



**National
Semiconductor
Corporation**

Linear Applications Databook



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A handwritten signature in black ink, reading 'Charles E. Sporck'. The signature is fluid and cursive, with the first letters of the first and last names being capitalized and prominent.

Charles E. Sporck
President, Chief Executive Officer
National Semiconductor Corporation

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Charles E. Sporck
President, Chief Executive Officer
National Semiconductor Corporation

LINEAR APPLICATIONS DATABOOK

NATIONAL SEMICONDUCTOR

The purpose of this databook is to provide a fully indexed and cross-referenced collection of linear integrated circuit applications using both monolithic and hybrid circuits from National Semiconductor.

Individual application notes are normally written to explain the operation and use of one particular device or to detail various methods of accomplishing a given function. The organization of this databook takes advantage of this innate coherence by keeping each application note intact, arranging them in numerical order, and providing a detailed Subject Index.

Many of the application schematics call out the generic family, which, by coincidence, is the military temperature range version of the device. Generally, any device in the generic family will work in the circuit. For example, an amplifier marked LM108 refers to the generic 108 family, and does not imply that only military-grade devices will work. Military (or industrial) grade devices need only be considered when their tighter electrical limits or wider temperature range warrant their use. As a reminder to our users, our numbering system is:

Device No.	Grade	Specified Temperature Range
LM1XX	Military	$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$
LM2XX	Industrial	$-25^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$
LM3XX	Commercial	$0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$

Because commercial parts are less expensive than military or industrial, these points should be kept in mind when trying to determine the most cost-effective approach to a given design.

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Drift Compensation Techniques for Integrated DC Amplifiers

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Introduction

With DC amplifiers, it is usually possible to substantially improve drift performance by using additional circuitry along with some form of adjustment. In fact, one of the reasons that discrete-component operational amplifiers have better input current specifications than monolithic amplifiers is that current compensation is used. Monolithic circuits cannot incorporate these techniques because it is not possible to select components or make adjustments. These adjustments can, however, be made external to the amplifier. This article will discuss a number of compensation methods which can substantially reduce the input currents of monolithic amplifiers, especially in limited-temperature-range applications.

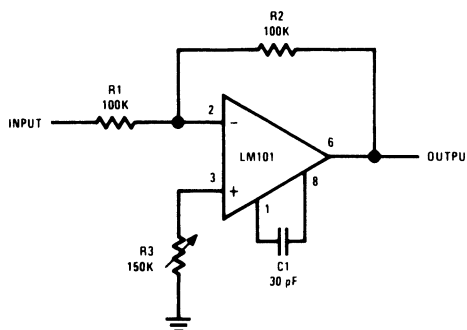
Bias current compensation reduces offset and drift when the amplifier is operated from high source resistances. With low source resistances, such as a thermocouple, the drift contribution due to bias current can be made quite small. In this case, the offset voltage drift becomes important.

A technique is presented here by which offset voltage drifts better than $0.5 \mu\text{V}/^\circ\text{C}$ can be realized. The compensation technique involves only a single room-temperature balance adjustment. Therefore, chopper-stabilized performance can be realized, with low source resistances, in a fairly-simple amplifier without tedious cut-and-try compensation methods.

bias current compensation

The simplest and most effective way of compensating for bias currents is shown in *Figure 1*. Here, the offset produced by the bias current on the inverting input is cancelled by the offset voltage produced across the variable resistor, R_3 . The main advantage of this scheme, besides its simplicity, is that the bias currents of the two input transistors tend to track well over temperature so that low drift is also achieved. The disadvantage of the method is that a given compensation setting works only with fixed feedback resistors, and the compensation must be readjusted if the equivalent parallel resistance of R_1 and R_2 is changed.

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Application Note 3



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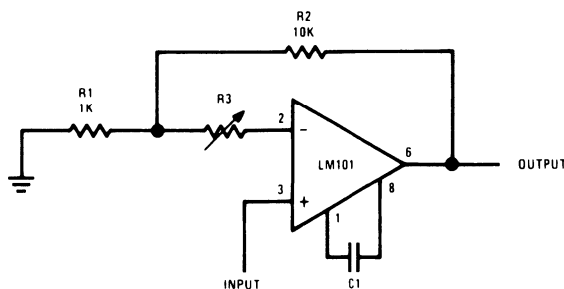
Figure 1. Summing amplifier with bias-current compensation for fixed source resistances

Figure 2 shows a similar circuit for a non-inverting amplifier. The offset voltage produced across the DC resistance of the source due to the input current is cancelled by the drop across R_3 . For proper adjustment range, R_3 should have a maximum value about three times the source resistance and the equivalent parallel resistance of R_1 and R_2 should be less than one-third the input source resistance.

This circuit has the same advantages as that in *Figure 1*, however, it can only be used when the input source has a fixed DC resistance. In many applications, such as long-interval integrators, sample-and-hold circuits, switched-gain amplifiers or voltage followers operating from unknown source, the source impedance is not defined. In these cases other compensation schemes must be used.

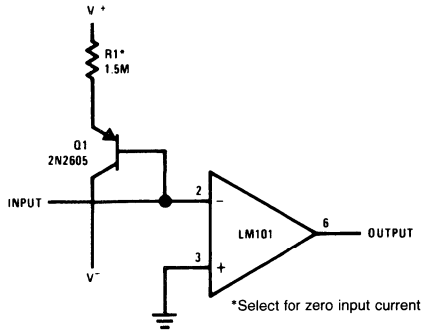
Figure 3 gives a compensation technique which does not depend upon having a fixed source resistance. A current is injected into the input terminal from the base of a PNP transistor. Since NPN input transistors are used on the integrated amplifier,* the base current of the PNP balances out the

*This is true for all monolithic operational amplifiers presently available.



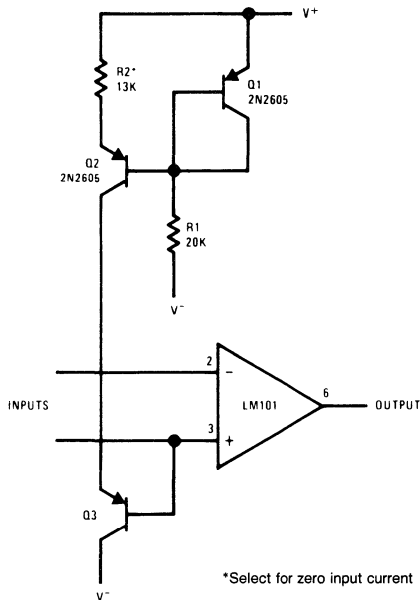
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Figure 2. Non-inverting amplifier with bias-current compensation for fixed source resistances



TL/H/6925-3

Figure 3. Summing amplifier with bias-current compensation



TL/H/6925-4

Figure 4. Bias-current compensation for non-inverting amplifier operated over large common mode range

base current of the NPN. Further, since a silicon-planar PNP transistor has approximately the same current-gain versus temperature characteristic as the integrated transistors, an improvement in temperature drift will also be realized.[†] However, perfect compensation should not be expected because of unit-to-unit variations in the temperature characteristics of both the PNP transistor and the integrated circuit.

Although the circuit in *Figure 3* works well for the summing amplifier connection, it does have limitations in other applications. It could, for example, be used for the voltage follower configuration by connecting the base of the PNP to the non-inverting input. However, this would reduce the input

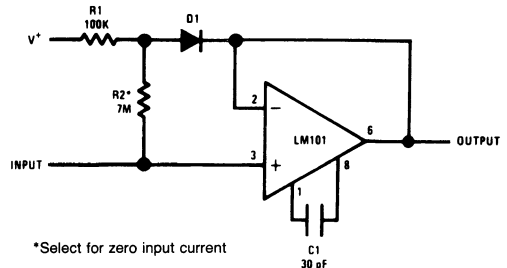
[†]If the operational amplifier uses a Darlington input stage, however, the drift compensation will not be nearly as good.

impedance (to about 150 M Ω) because the current supplied by the PNP will vary with the input voltage level.

If this characteristic is objectionable, the more-complicated circuit shown in *Figure 4* can be used.

The emitter of the PNP transistor is fed from a current source so that the compensating current does not vary with input-voltage level. The design of the current source is such as to give it about the same characteristics as those on the input stage of the better monolithic amplifiers[‡] to give closer compensation with changes in temperature and supply voltage. The circuit makes use of the emitter base voltage differential between two transistors operated at different collector currents.^{1,2} Although it is recommended in the references that these transistors be well matched, it is not really necessary since the devices are operated at much different collector currents.

Figure 5 shows another compensation scheme for the voltage follower connection. This circuit is much simpler than that shown in *Figure 4*, but the temperature compensation is not quite as good. The compensating current is obtained through a resistor connected across a diode which is bootstrapped to the output. The diode acts as a regulator so that the compensating current does not change appreciably with signal level, giving input impedances about 1000 M Ω . The negative temperature coefficient of the diode voltage also provides some temperature compensation.



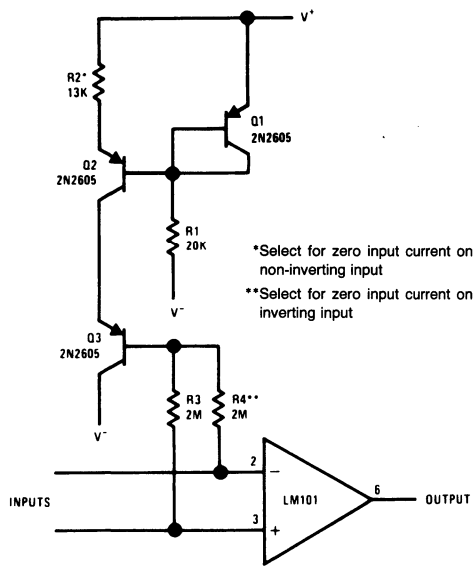
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Figure 5. Voltage follower with bias-current compensation

All the circuits discussed thus far have been tailored for particular applications. *Figure 6* shows a completely-general scheme wherein both inputs are current compensated over the full common mode range as well as against power supply and temperature variations. This circuit is suitable for use either as a summing amplifier or as a non-inverting amplifier. It is not required that the DC impedance seen by both inputs be equal, although lower drift can be expected if they are.

As was mentioned earlier, all the bias compensation circuits require adjustment. With the circuits in *Figures 1* and *2*, this is merely a matter of adjusting the potentiometer for zero output with zero input. It is not so simple with the other circuits, however. For one, it is difficult to use potentiometers because a very wide range of resistance values are required to accommodate expected unit-to-unit variations. Resistor selection must therefore be used. Test circuits for selecting bias compensation resistors are given in *Figure 7*.

[‡]The 709 and the LM101.



TL/H/6925-6

Figure 6. Bias-current compensation for differential inputs

offset voltage compensation

The highly predictable behavior of the emitter-base voltage of transistors has suggested a unique drift compensation method; it is shown in Reference 3 that the offset voltage drift of a differential transistor pair can be reduced by about an order of magnitude by unbalancing the collector currents such that the initial offset voltage is zero. The basis for this comes from the equation for the emitter-base voltage differential of two transistors operating at the same temperature:

$$\Delta V_{BE} = \frac{kT}{q} \log_e \frac{I_{S2}}{I_{S1}} - \frac{kT}{q} \log_e \frac{I_{C2}}{I_{C1}} \quad (1)$$

where k is Boltzmann's constant, T is the absolute temperature, q is the charge of an electron, I_S is a constant which depends only on how the transistor is made and I_C is the collector current. This equation is derived in Reference 2.

It is worthwhile noting here that these expressions make no assumptions about the current gain of the transistors. It is shown in References 5 and 6 that the emitter-base voltage is a function of collector current, not emitter current. Therefore, the balance will not be upset by base current (except for interaction with the DC source resistance).

The first term in Equation (1) is the offset voltage of the two transistors for equal collector currents. It can be seen that this offset voltage is directly proportional to the absolute temperature—a fact which is substantiated by experiment.⁴ The second term is the change of offset voltage which arises from operating the transistors at unequal collector currents. For a fixed ratio of collector currents, this is also proportional to absolute temperature. Hence, if the collector currents are unbalanced in a fixed ratio to give a zero emitter-base voltage differential, the temperature drift will also be zero.

Experiment indicates that this is indeed true. Thermal drifts less than $100 \mu\text{V}$ over the -55°C to $+125^\circ\text{C}$ temperature range have been realized consistently. In order to obtain these low drifts, however, it is almost necessary to use a monolithic transistor pair, since a 0.05°C temperature differential will give a $100 \mu\text{V}$ drift. With a monolithic pair, the physical proximity of the devices as well as the high thermal conductivity of silicon holds this differential to an absolute minimum.

For low drift, the transistors must operate from a low enough source resistance that the voltage drop across the source due to base current (or base current differential if both bases see the same resistance) is insignificant. Furthermore, the transistors must be operated at a low enough collector current that the emitter-contact and base-spreading resistances are negligible, since Equation (1) assumes that they are zero.

A complete amplifier using this principle is shown in Figure 8. A monolithic transistor pair is used as a preamplifier for a conventional operational amplifier. A null potentiometer, which is set for zero output for zero input, unbalances the collector load resistors of the transistor pair such that the collector currents are unbalanced for zero offset. This gives minimum drift. An interesting feature of the circuit is that the performance is relatively unaffected by supply voltage variations: a 1V change in either supply causes an offset voltage change of about $10 \mu\text{V}$. This happens because neither term in Equation (1) is affected by the magnitude of the collector currents.

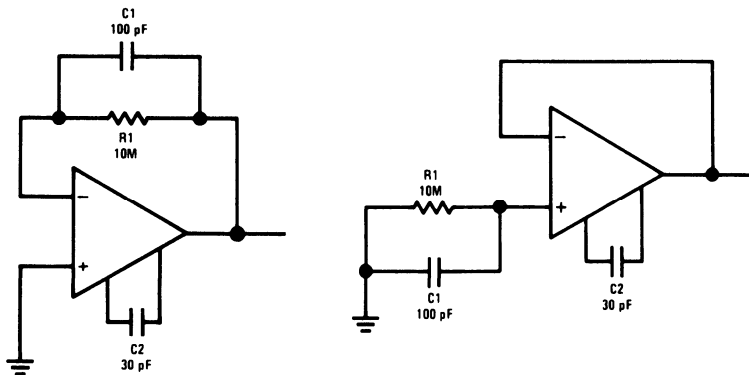


Figure 7. Test circuits for selecting bias-compensation resistors

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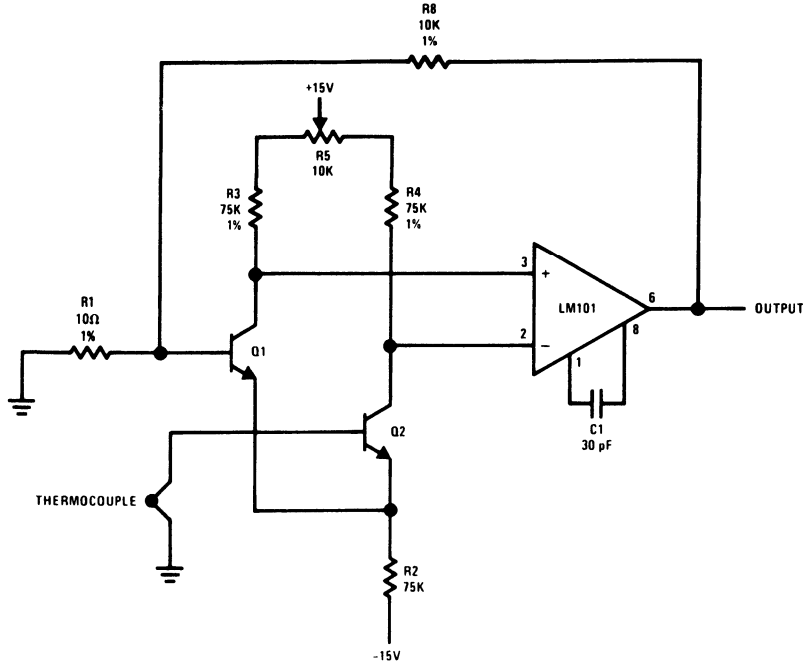


Figure 8. Example of a DC amplifier using the drift-compensation technique

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In order to get low drift, it is necessary that the gain of the preamplifier be high enough so that the drift of the operational amplifier does not degrade performance. The gain can be determined from the expression for the transconductance of the input transistors:

$$\frac{\partial I_C}{\partial V_{BE}} = \frac{qI_C}{kT} \quad (2)$$

The voltage gain is

$$A_V = \frac{\partial V_{OUT}}{\partial V_{IN}} \quad (3)$$

$$= \frac{\partial I_C}{\partial V_{BE}} R_L \quad (4)$$

where R_L is the average value of the two collector load resistors on the input stage and I_C is the average of the two collector currents.

Substituting Equation (2), this becomes

$$A_V = \frac{qI_C R_L}{kT} \quad (5)$$

$$= \frac{qV_{RL}}{kT} \quad (6)$$

The input referred drift is then

$$\Delta V_{IN} = \frac{\Delta V_{OS} + R_L \Delta I_{OS}}{A_V}$$

where ΔV_{OS} is the offset voltage drive of the operational amplifier and ΔI_{OS} is its offset current drift.

Using Equation (7),

$$\Delta V_{IN} = \frac{kT (\Delta V_{OS} + R_L \Delta I_{OS})}{qV_{RL}} \quad (8)$$

With the circuit shown in Figure 8, Equation (8) gives a 25 μV input-referred drift for every 10 mV of offset voltage drift or for every 100 nA of offset current drift. It is obvious from this that the offset current drift is most important if an operational amplifier with bipolar input transistors is used.

Another important consideration is the matching of the collector load resistors on the preamplifier stage. A 0.1-percent imbalance in the load resistors due to thermal mismatches or any other cause will produce a 25 μV shift in offset. This includes the balancing potentiometer which can introduce an error that will depend on how far it is set off midpoint if it has a different temperature coefficient than the resistors.

The most obvious use of this type of low drift amplifier is with thermocouples, magnetometers, current shunts, wire strain gauges or similar signal sources where very low drift is required and the source resistance is low enough that the bias currents do not cause a problem. The 0.5 to 1 $\mu V/^{\circ}C$ drift* realized with this relatively simple amplifier over a $-55^{\circ}C$ to $+125^{\circ}C$ temperature range compares favorably with the drift figures achieved with chopper amplifiers: 0.4 $\mu V/^{\circ}C$ for mechanical choppers, 0.5 $\mu V/^{\circ}C$ with photoelectric choppers over a $0^{\circ}C$ to $55^{\circ}C$ temperature range and 2 $\mu V/^{\circ}C$ with field-effect-transistor choppers over a $-55^{\circ}C$ to $+125^{\circ}C$ temperature range. In order to give some appreciation of the level of performance, it is interesting to note that no substantial improvement in performance would be realized by operating the amplifier in a temperature-controlled oven. Any improvement would be masked by various thermo-electric effects not directly associated with the amplifier unless extreme care were taken in the choice of input lead

*Drifts of 0.05 $\mu V/^{\circ}C$ over a $0-50^{\circ}C$ temperature range were reported in Reference 3 using matched discrete transistors in one can.

material, the method of making connections and the balancing of thermal paths. These factors are, in fact, important when making oven tests to verify the drift of the amplifier since thermoelectric effects can easily produce drift voltages larger than those of the amplifier if they are not properly handled.

summary

A number of compensation circuits designed to increase the DC resolution of monolithic operational amplifiers have been presented. Both current compensation techniques for high impedance levels as well as methods of achieving chopper-stabilized drift performance at low impedance levels have been covered.

Fairly-simple current compensation which requires that the impedance levels be fixed have been described along with compensation which is effective in cases where the source impedance is not well defined. This latter category includes long-interval integrators, sample-and-hold circuits, switched-gain amplifiers or voltage followers which operate from an unknown source. The application of these schemes is generally limited to integrated amplifiers since modular amplifiers almost always incorporate current compensation.

The drift-reduction techniques provide stabilities better than $0.5 \mu\text{V}/^\circ\text{C}$ for low impedance sources, such as thermocouples, current shunts or strain gauges. With a properly designed circuit, compensation depends only on a single room temperature adjustment, so excellent performance can be obtained from a fairly-simple amplifier.

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Monolithic Op Amp—The Universal Linear Component

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National Semiconductor
Application Note 4



Introduction

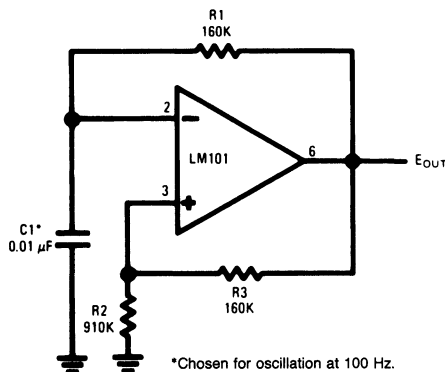
Operational amplifiers are undoubtedly the easiest and best way of performing a wide range of linear functions from simple amplification to complex analog computation. The cost of monolithic amplifiers is now less than \$2.00, in large quantities, which makes it attractive to design them into circuits where they would not otherwise be considered. Yet low cost is not the only attraction of monolithic amplifiers. Since all components are simultaneously fabricated on one chip, much higher circuit complexities than can be used with discrete amplifiers are economical. This can be used to give improved performance. Further, there are no insurmountable technical difficulties to temperature stabilizing the amplifier chip, giving chopper-stabilized performance with little added cost.

Operational amplifiers are designed for high gain, low offset voltage and low input current. As a result, dc biasing is considerably simplified in most applications; and they can be used with fairly simple design rules because many potential error terms can be neglected. This article will give examples demonstrating the range of usefulness of operational amplifiers in linear circuit design. The examples are certainly not all-inclusive, and it is hoped that they will stimulate even more ideas from others. A few practical hints on preventing oscillations in operational amplifiers will also be given since this is probably the largest single problem that many engineers have with these devices.

Although the designs presented use the LM101 operational amplifier and the LM102 voltage follower produced by National Semiconductor, most are generally applicable to all monolithic devices if the manufacturer's recommended frequency compensation is used and differences in maximum ratings are taken into account. A complete description of the LM101 is given elsewhere;¹ but, briefly, it differs from most other monolithic amplifiers, such as the LM709,² in that it has a $\pm 30\text{V}$ differential input voltage range, a $+15\text{V}$, -12V common mode range with $\pm 15\text{V}$ supplies and it can be compensated with a single 30 pF capacitor. The LM102,³ which is also used here, is designed specifically as a voltage follower and features a maximum input current of 10 nA and a $10\text{ V}/\mu\text{s}$ slew rate.

operational-amplifier oscillator

The free-running multivibrator shown in Figure 1 is an excellent example of an application where one does not normally consider using an operational amplifier. However, this circuit operates at low frequencies with relatively small capacitors because it can use a longer portion of the capacitor time constant since the threshold point of the operational amplifier is well determined. In addition, it has a completely-symmetrical output waveform along with a buffered output, although the symmetry can be varied by returning R2 to some voltage other than ground.



TL/H/7357-1

Figure 1. Free-running multivibrator

Another advantage of the circuit is that it will always self start and cannot hang up since there is more dc negative feedback than positive feedback. This can be a problem with many "textbook" multivibrators.

Since the operational amplifier is used open loop, the usual frequency compensation components are not required since they will only slow it down. But even without the 30 pF capacitor, the LM101 does have speed limitations which restrict the use of this circuit to frequencies below about 2 kHz .

The large input voltage range of the LM101 (both differential and single ended) permits large voltage swings on the input so that several time constants of the timing capacitor, C1, can be used. With most other amplifiers, R2 must be reduced to keep from exceeding these ratings, which requires that C1 be increased. Nonetheless, even when large values are needed for C1, smaller polarized capacitors may be used by returning them to the positive supply voltage instead of ground.

level shifting amplifier

Frequently, in the design of linear equipment, it is necessary to take a voltage which is referred to some dc level and produce an amplified output which is referred to ground. The most straight-forward way of doing this is to use a differential amplifier similar to that shown in Figure 2a. This circuit, however, has the disadvantages that the signal source is loaded by current from the input divider, R3 and R4, and that the feedback resistors must be very well matched to prevent erroneous outputs from the common mode input signal.

A circuit which does not have these problems is shown in *Figure 2b*. Here, an FET transistor on the output of the operational amplifier produces a voltage drop across the feedback resistor, R1, which is equal to the input voltage. The voltage across R2 will then be equal to the input voltage multiplied by the ratio, R2/R1; and the common mode rejection will be as good as the basic rejection of the amplifier, independent of the resistor tolerances. This voltage is buffered by an LM102 voltage follower to give a low impedance output.

An advantage of the LM101 in this circuit is that it will work with input voltages up to its positive supply voltages as long as the supplies are less than $\pm 15V$.

voltage comparators

The LM101 is well suited to comparator applications for two reasons: first, it has a large differential input voltage range and, second, the output is easily clamped to make it compatible with various driver and logic circuits. It is true that it doesn't have the speed of the LM7104 (10 μs versus 40 ns, under equivalent conditions); however, in many linear applications speed is not a problem and the lower input currents along with higher voltage capability of the LM101 is a tremendous benefit.

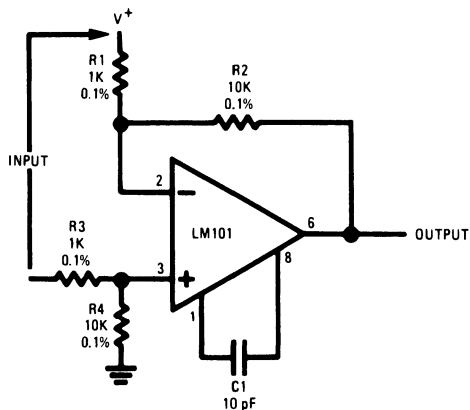
Two comparator circuits using the LM101 are shown in *Figure 3*. The one in *Figure 3a* shows a clamping scheme

which makes the output signal directly compatible with DTL or TTL integrated circuits. An LM103 breakdown diode clamps the output at 0V or 4V in the low or high states, respectively. This particular diode was chosen because it has a sharp breakdown and low equivalent capacitance. When working as a comparator, the amplifier operates open loop so normally no frequency compensation is needed. Nonetheless, the stray capacitance between Pins 5 and 6 of the amplifier should be minimized to prevent low level oscillations when the comparator is in the active region. If this becomes a problem a 3 pF capacitor on the normal compensation terminals will eliminate it.

Figure 3b shows the connection of the LM101 as a comparator and lamp driver. Q1 switches the lamp, with R2 limiting the current surge resulting from turning on a cold lamp. R1 determines the base drive to Q1 while D1 keeps the amplifier from putting excessive reverse bias on the emitter-base junction of Q1 when it turns off.

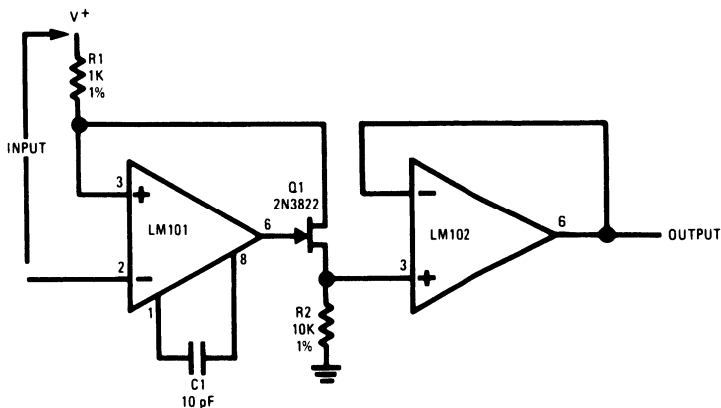
more output current swing

Because almost all monolithic amplifiers use class-B output stages, they have good loaded output voltage swings, delivering $\pm 10V$ at 5 mA with $\pm 15V$ supplies. Demanding much more current from the integrated circuit would require, for one, that the output transistors be made considerably larg-



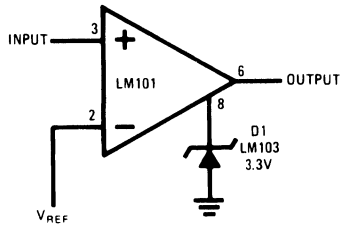
a. standard differential amplifier

TL/H/7357-2



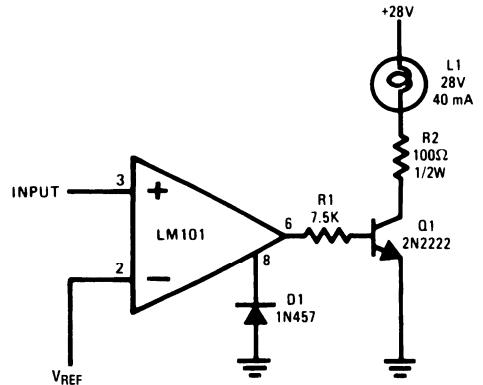
b. level-isolation amplifier
Figure 2. Level-shifting amplifiers

TL/H/7357-3



TL/H/7357-4

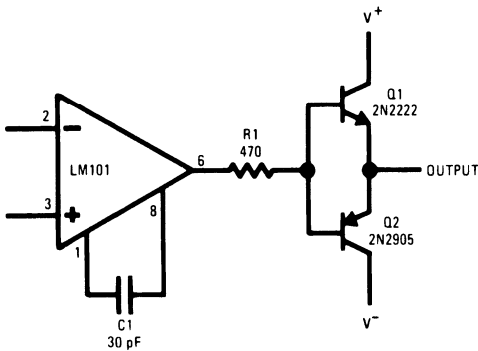
a. comparator for driving DTL and TTL integrated circuits



TL/H/7357-5

b. comparator and lamp driver

Figure 3. Voltage comparator circuits



TL/H/7357-6

Figure 4. High current output buffer

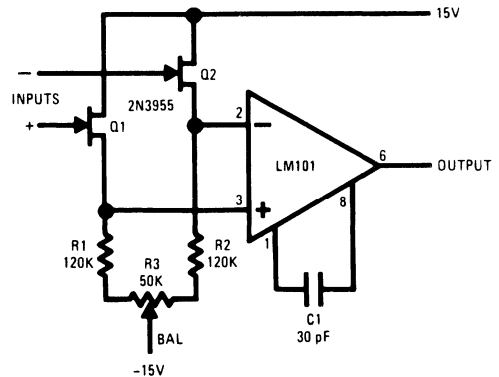
er. In addition, the increased dissipation could give rise to troublesome thermal gradients on the chip as well as excessive package heating in high-temperature applications. It is therefore advisable to use an external buffer when large output currents are needed.

A simple way of accomplishing this is shown in *Figure 4*. A pair of complementary transistors are used on the output of the LM101 to get the increased current swing. Although this circuit does have a dead zone, it can be neglected at frequencies below 100 Hz because of the high gain of the amplifier. R1 is included to eliminate parasitic oscillations from the output transistors. In addition, adequate bypassing should be used on the collectors of the output transistors to insure that the output signal is not coupled back into the amplifier. This circuit does not have current limiting, but it can be added by putting 50Ω resistors in series with the collectors of Q1 and Q2.

an fet amplifier

For ambient temperatures less than about 70°C, junction field effect transistors can give exceptionally low input currents when they are used on the input stage of an operational amplifier. However, monolithic FET amplifiers are not now available since it is no simple matter to diffuse high quality FET's on the same chip as the amplifier. Nonetheless, it is possible to make a good FET amplifier using a discrete FET pair in conjunction with a monolithic circuit.

Such a circuit is illustrated in *Figure 5*. A matched FET pair, connected as source followers, is put in front of an integrated operational amplifier. The composite circuit has roughly the same gain as the integrated circuit by itself and is compensated for unity gain with a 30 pF capacitor as shown. Although it works well as a summing amplifier, the circuit leaves something to be desired in applications requiring high common mode rejection. This happens both because resistors are used for current sources and because the FET's by themselves do not have good common mode rejection.



TL/H/7357-7

Figure 5. FET operational amplifier

storage circuits

A sample-and-hold circuit which combines the low input current of FET's with the low offset voltage of monolithic amplifiers is shown in *Figure 6*. The circuit is a unity gain amplifier employing an operational amplifier and an FET source follower. In operation, when the sample switch, Q2, is turned on, it closes the feedback loop to make the output equal to the input, differing only by the offset voltage of the LM101. When the switch is opened, the charge stored on C2 holds the output at a level equal to the last value of the input voltage.

Some care must be taken in the selection of the holding capacitor. Certain types, including paper and mylar, exhibit a polarization phenomenon which causes the sampled volt-

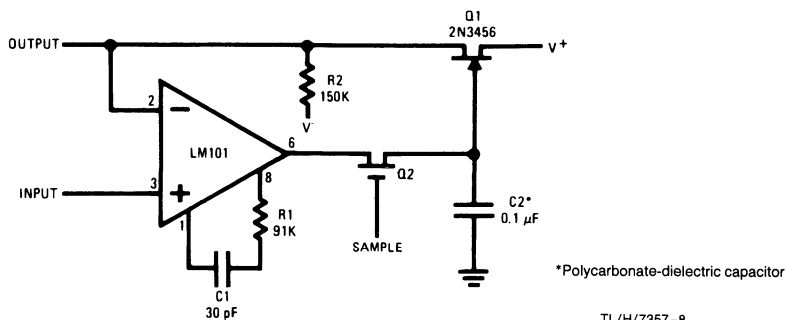


Figure 6. Low drift sample and hold

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age to drop off by about 50 mV, and then stabilize, when the capacitor is exercised over a 5V range during the sample interval. This drop off has a time constant in the order of seconds. The effect, however, can be minimized by using capacitors with teflon, polyethylene, glass or polycarbonate dielectrics.

Although this circuit does not have a particularly low output resistance, fixed loads do not upset the accuracy since the loading is automatically compensated for during the sample interval. However, if the load is expected to change after sampling, a buffer such as the LM102 must be added between the FET and the output.

A second pole is introduced into the loop response of the amplifier by the switch resistance and the holding capacitor, C2. This can cause problems with overshoot or oscillation if it is not compensated for by adding a resistor, R1, in series with the LM101 compensation capacitor such that the breakpoint of the R1C1 combination is roughly equal to that of the switch and the holding capacitor.

It is possible to use an MOS transistor for Q1 without worrying about the threshold stability. The threshold voltage is balanced out during every sample interval so only the short-term threshold stability is important. When MOS transistors are used along with mechanical switches, drift rates less than 10 mV/min can be realized.

Additional features of the circuit are that the amplifier acts as a buffer so that the circuit does not load the input signal.

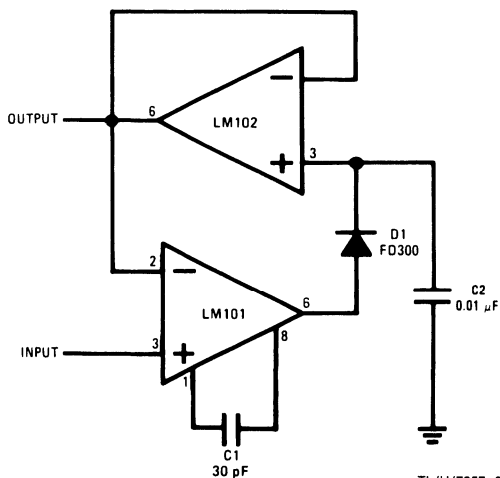


Figure 7. Positive peak detector with buffered output

TL/H/7357-9

Further, gain can also be provided by feeding back to the inverting input of the LM101 through a resistive divider instead of directly.

The peak detector in *Figure 7* is similar in many respects to the sample-and-hold circuit. A diode is used in place of the sampling switch. Connected as shown, it will conduct whenever the input is greater than the output, so the output will be equal to the peak value of the input voltage. In this case, an LM102 is used as a buffer for the storage capacitor, giving low drift along with a low output resistance.

As with the sample and hold, the differential input voltage range of the LM101 permits differences between the input and output voltages when the circuit is holding.

non-linear amplifiers

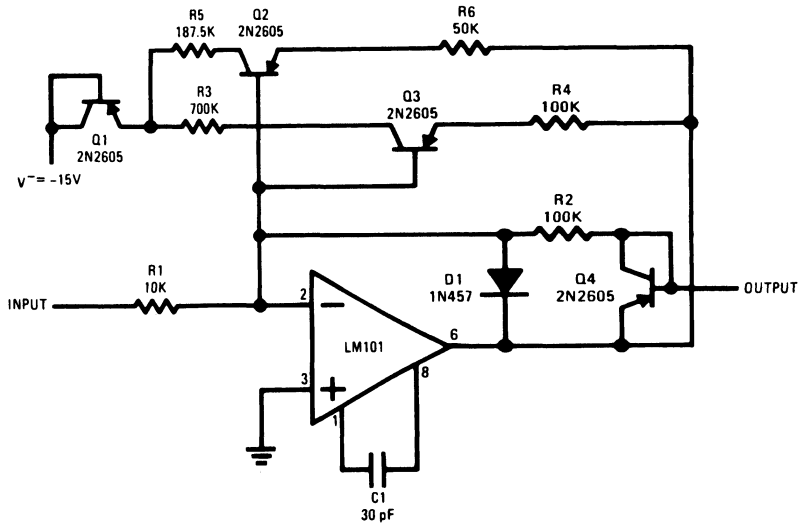
When a non-linear transfer function is needed from an operational amplifier, many methods of obtaining it present themselves. However, they usually require diodes and are therefore difficult to temperature compensate for accurate breakpoints. One way of getting around this is to make the output swing so large that the diode threshold is negligible by comparison, but this is not always practical.

A method of producing very sharp, temperature-stable breakpoints in the transfer function of an operational amplifier is shown in *Figure 8*. For small input signals, the gain is determined by R1 and R2. Both Q2 and Q3 are conducting to some degree, but they do not affect the gain because their current gain is high and they do not feed any appreciable current back into the summing mode. When the output voltage rises to 2V (determined by R3, R4 and V⁻), Q3 draws enough current to saturate, connecting R4 in parallel with R2. This cuts the gain in half. Similarly, when the output voltage rises to 4V, Q2 will saturate, again halving the gain.

Temperature compensation is achieved in this circuit by including Q1 and Q4. Q4 compensates the emitter-base voltage of Q2 and Q3 to keep the voltage across the feedback resistors, R4 and R6, very nearly equal to the output voltage while Q1 compensates for the emitter base voltage of these transistors as they go into saturation, making the voltage across R3 and R5 equal to the negative supply voltage. A detrimental effect of Q4 is that it causes the output resistance of the amplifier to increase at high output levels. It may therefore be necessary to use an output buffer if the circuit must drive an appreciable load.

servo preamplifier

In certain servo systems, it is desirable to get the rate signal required for loop stability from some sort of electrical, lead network. This can, for example, be accomplished with reactive elements in the feedback network of the servo preamplifier.



TL/H/7357-10

Figure 8. Nonlinear operational amplifier with temperature-compensated breakpoints

Many saturating servo amplifiers operate over an extremely wide dynamic range. For example, the maximum error signal could easily be 1000 times the signal required to saturate the system. Cases like this create problems with electrical rate networks because they cannot be placed in any part of the system which saturates. If the signal into the rate network saturates, a rate signal will only be developed over a narrow range of system operation; and instability will result when the error becomes large. Attempts to place the rate networks in front of the error amplifier or make the error amplifier linear over the entire range of error signals frequently gives rise to excessive dc error from signal attenuation.

These problems can be largely overcome using the kind of circuit shown in *Figure 9*. This amplifier operates in the linear mode until the output voltage reaches approximately 3V with 30 μ A output current from the solar cell sensors. At this point the breakdown diodes in the feedback loop begin to conduct, drastically reducing the gain. However, a rate sig-

nal will still be developed because current is being fed back into the rate network (R1, R2 and C1) just as it would if the amplifier had remained in the linear operating region. In fact, the amplifier will not actually saturate until the error current reaches 6 mA, which would be the same as having a linear amplifier with a ± 600 V output swing.

computing circuits

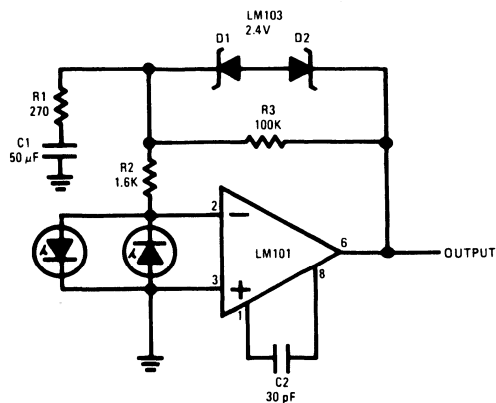
In analog computation it is a relatively simple matter to perform such operations as addition, subtraction, integration and differentiation by incorporating the proper resistors and capacitors in the feedback circuit of an amplifier. Many of these circuits are described in reference 5. Multiplication and division, however, are a bit more difficult. These operations are usually performed by taking the logarithms of the quantities, adding or subtracting as required and then taking the antilog.

At first glance, it might appear that obtaining the log of a voltage is difficult; but it has been shown⁶ that the emitter-base voltage of a silicon transistor follows the log of its collector current over as many as nine decades. This means that common transistors can be used to perform the log and antilog operations.

A circuit which performs both multiplication and division in this fashion is shown in *Figure 10*. It gives an output which is proportional to the product of two inputs divided by a third, and it is about the same complexity as a divider alone.

The circuit consists of three log converters and an antilog generator. Log converters similar to these have been described elsewhere,⁷ but a brief description follows. Taking amplifier A1, a logging transistor, Q1, is inserted in the feedback loop such that its collector current is equal to the input voltage divided by the input resistor, R1. Hence, the emitter-base voltage of Q1 will vary as the log of the input voltage E1.

A2 is a similar amplifier operating with logging transistor, Q2. The emitter-base junctions of Q1 and Q2 are connected in series, adding the log voltages. The third log converter produces the log of E3. This is series-connected with the antilog transistor, Q4; and the combination is hooked in par-



TL/H/7357-11

Figure 9. Saturating servo preamplifier with rate feedback

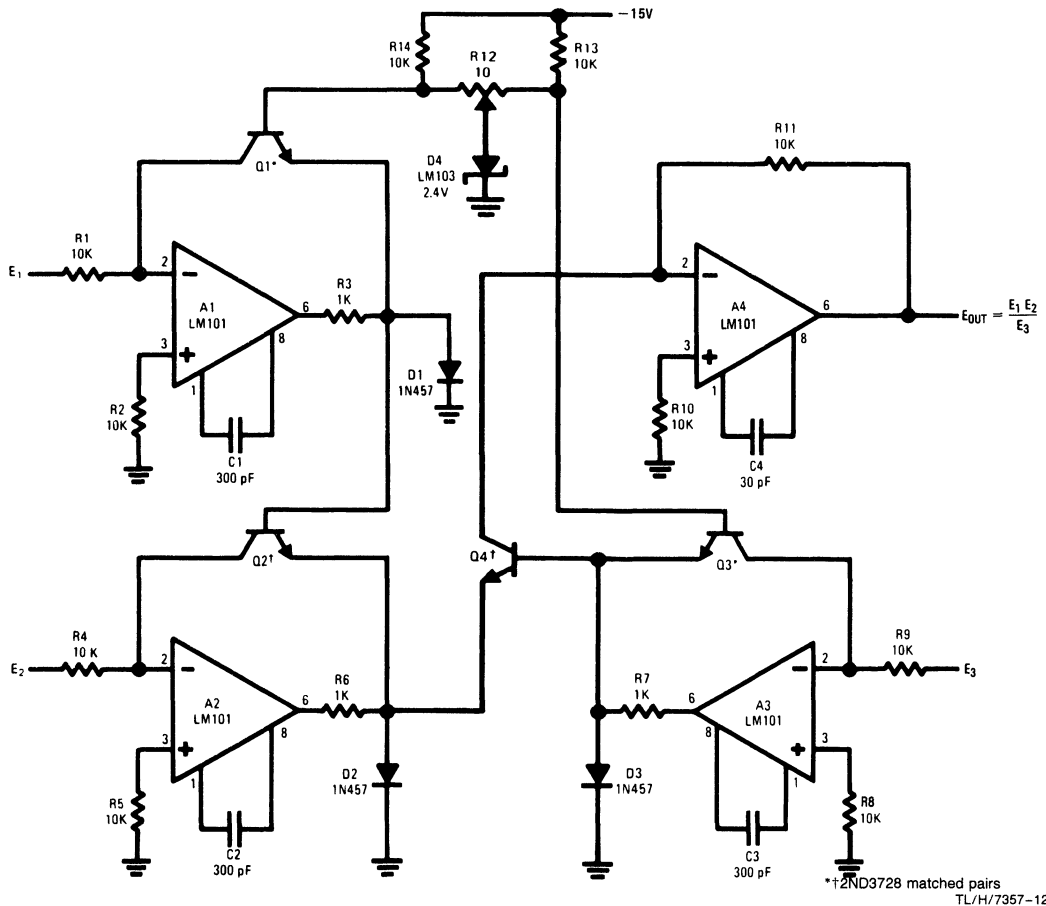


Figure 10. Analog multiplier/divider

allel with the output of the other two log converters. Therefore, the emitter-base of Q4 will see the log of E3 subtracted from the sum of the logs of E1 and E2. Since the collector current of a transistor varies as the exponent of the emitter-base voltage, the collector current of Q4 will be proportional to the product of E1 and E2 divided by E3. This current is fed to the summing amplifier, A4, giving the desired output.

This circuit can give 1-percent accuracy for input voltages from 500 mV to 50V. To get this precision at lower input voltages, the offset of the amplifiers handling them must be individually balanced out. The zener diode, D4, increases the collector-base voltage across the logging transistors to improve high current operation. It is not needed, and is in fact undesirable, when these transistors are running at currents less than 0.3 mA. At currents above 0.3 mA, the lead resistances of the transistors can become important (0.25Ω is 1-percent at 1 mA) so the transistors should be installed with short leads and no sockets.

An important feature of this circuit is that its operation is independent of temperature because the scale factor change in the log converter with temperature is compensated by an equal change in the scale factor of the antilog generator. It is only required that Q1, Q2, Q3 and Q4 be at the same temperature. Dual transistors should be used and arranged as shown in the figure so that thermal mismatches

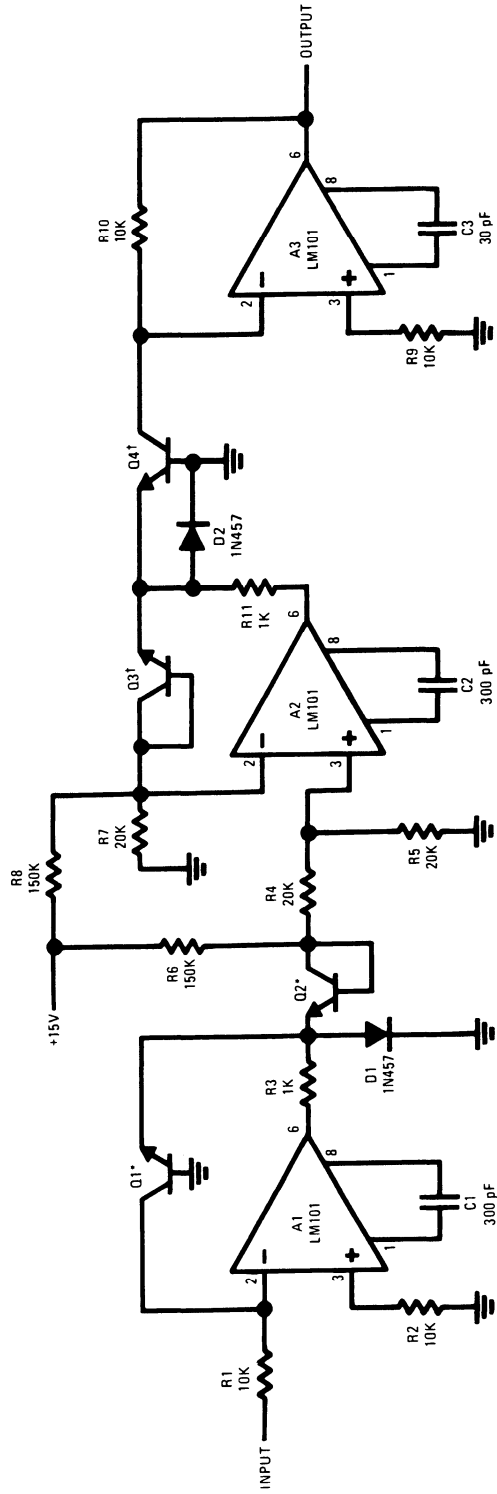
between cans appear as inaccuracies in scale factor (0.3-percent/°C) rather than a balance error (8-percent/°C). R12 is a balance potentiometer which nulls out the offset voltages of all the logging transistors. It is adjusted by setting all input voltages equal to 2V and adjusting for a 2V output voltage.

The logging transistors provide a gain which is dependent on their operating level, which complicates frequency compensation. Resistors (R3, R6 and R7) are put in the amplifier output to limit the maximum loop gain, and the compensation capacitor is chosen to correspond with this gain. As a result, the amplifiers are not especially designed for speed, but techniques for optimizing this parameter are given in reference 6.

Finally, clamp diodes D1 through D3, prevent exceeding the maximum reverse emitter-base voltage of the logging transistors with negative inputs.

root extractor*

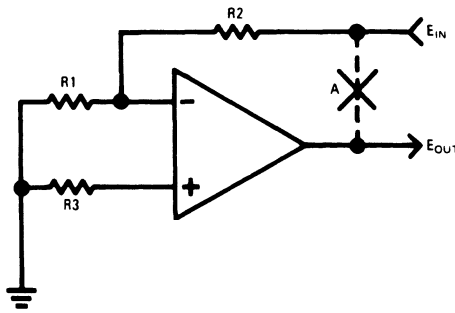
Taking the root of a number using log converters is a fairly simple matter. All that is needed is to take the log of a voltage, divide it by, say 1/2 for the square root, and then "The "extraction" used here doubtless has origin in the dental operation most of us would fear less than having to find even a square root without tables or other aids.



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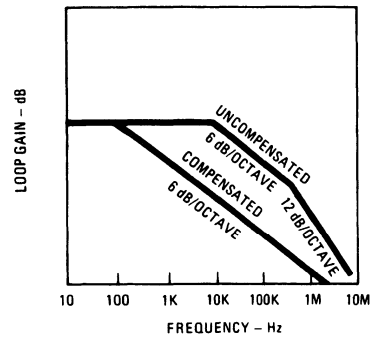
*12N3728 matched pairs

Figure 11. Root extractor



a. measuring loop gain

TL/H/7357-14



b. typical response

TL/H/7357-15

Figure 12. Illustrating loop gain

take the antilog. A circuit which accomplishes this is shown in *Figure 11*. A1 and Q1 form the log converter for the input signal. This feeds Q2 which produces a level shift to give zero voltage into the R4, R5 divider for a 1V input. This divider reduces the log voltage by the ratio for the root desired and drives the buffer amplifier, A2. A2 has a second level shifting diode, Q3, its feedback network which gives the output voltage needed to get a 1V output from the antilog generator, consisting of A3 and Q4, with a unity input. The offset voltages of the transistors are nulled out by imbalancing R6 and R8 to give 1V output for 1V input, since any root of one is one.

Q2 and Q3 are connected as diodes in order to simplify the circuitry. This doesn't introduce current problems because both operate over a very limited current range, and it is really only required that they match. R7 is a gain-compensating resistor which keeps the currents in Q2 and Q3 equal with changes in signal level.

As with the multiplier/divider, the circuit is insensitive to temperature as long as all the transistors are at the same temperature. Using transistor pairs and matching them as shown minimizes the effects of gradients.

The circuit has 1-percent accuracy for input voltages between 0.5 and 50V. For lower input voltages, A1 and A3 must have their offsets balanced out individually.

frequency compensation hints

The ease of designing with operational amplifiers sometimes obscures some of the rules which must be followed with any feedback amplifier to keep it from oscillating. In general, these problems stem from stray capacitance, excessive capacitive loading, inadequate supply bypassing or improper frequency compensation.

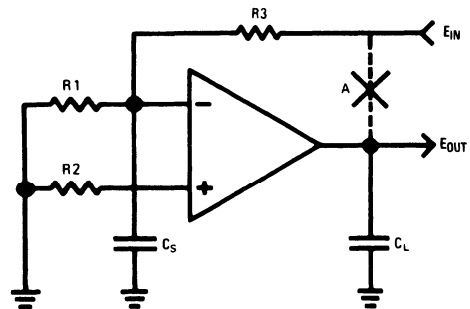
In frequency compensating an operational amplifier, it is best to follow the manufacturer's recommendations. However, if operating speed and frequency response is not a consideration, a greater stability margin can usually be obtained by increasing the size of the compensation capacitors. For example, replacing the 30 pF compensation capacitor on the LM101 with a 300 pF capacitor will make it ten times less susceptible to oscillation problems in the unity-gain connection. Similarly, on the LM709, using 0.05 μ F, 1.5 k Ω , 2000 pF and 51 Ω components instead of 5000 pF, 1.5 k Ω , 200 pF and 51 Ω will give 20 dB more stability margin. Capacitor values less than those specified by the manufacturer for a particular gain connection should not be used since they will make the amplifier more sensitive to strays

and capacitive loading, or the circuit can even oscillate with worst-case units.

The basic requirement for frequency compensating a feedback amplifier is to keep the frequency roll-off of the loop gain from exceeding 12 dB/octave when it goes through unity gain. *Figure 12a* shows what is meant by loop gain. The feedback loop is broken at the output, and the input sources are replaced by their equivalent impedance. Then the response is measured such that the feedback network is included.

Figure 12b gives typical responses for both uncompensated and compensated amplifiers. An uncompensated amplifier generally rolls off at 6 dB/octave, then 12 dB/octave and even 18 dB/octave as various frequency-limiting effects within the amplifier come into play. If a loop with this kind of response were closed, it would oscillate. Frequency compensation causes the gain to roll off at a uniform 6 dB/octave right down through unity gain. This allows some margin for excess rolloff in the external circuitry.

Some of the external influences which can affect the stability of an operational amplifier are shown in *Figure 13*. One is the load capacitance which can come from wiring, cables or an actual capacitor on the output. This capacitance works against the output impedance of the amplifier to attenuate high frequencies. If this added rolloff occurs before the loop gain goes through zero, it can cause instability. It should be remembered that this single rolloff point can give more than 6 dB/octave rolloff since the output impedance of the amplifier can be increasing with frequency.

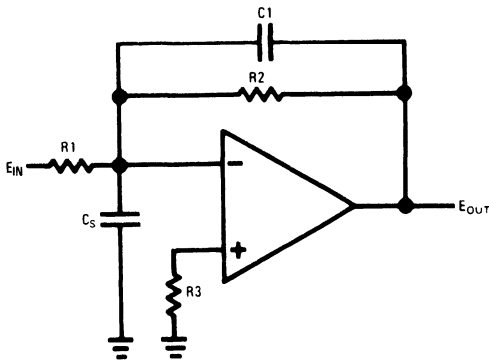


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Figure 13. External capacitances that affect stability

A second source of excess rolloff is stray capacitance on the inverting input. This becomes extremely important with large feedback resistors as might be used with an FET-input amplifier. A relatively simple method of compensating for this stray capacitance is shown in *Figure 14*: a lead capacitor, C1, put across the feedback resistor. Ideally, the ratio of the stray capacitance to the lead capacitor should be equal to the closed-loop gain of the amplifier. However, the lead capacitor can be made larger as long as the amplifier is compensated for unity gain. The only disadvantage of doing this is that it will reduce the bandwidth of the amplifier. Oscillations can also result if there is a large resistance on the non-inverting input of the amplifier. The differential input impedance of the amplifier falls off at high frequencies (especially with bipolar input transistors) so this resistor can produce troublesome rolloff if it is much greater than 10K, with most amplifiers. This is easily corrected by bypassing the resistor to ground.

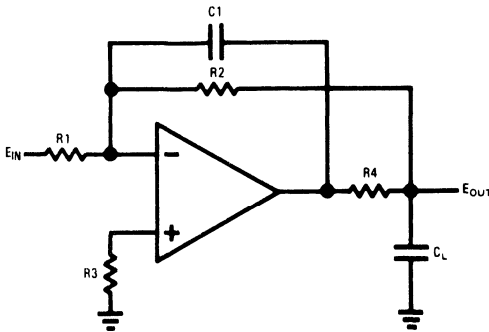
When the capacitive load on an integrated amplifier is much greater than 100 pF, some consideration must be given to its effect on stability. Even though the amplifier does not oscillate readily, there may be a worst-case set of conditions under which it will. However, the amplifier can be stabilized for any value of capacitive loading using the circuit



TL/H/7357-17

Figure 14. Compensating stray input capacitance

shown in *Figure 15*. The capacitive load is isolated from the output of the amplifier with R4 which has a value of 50Ω to 100Ω for both the LM101 and the LM709. At high frequencies, the feedback path is through the lead capacitor, C1, so that the lag produced by the load capacitance does not



TL/H/7357-18

Figure 15. Compensating for very large capacitive loads

cause instability. To use this circuit, the amplifier must be compensated for unity gain, regardless of the closed loop dc gain. The value of C1 is not too important, but at a minimum its capacitive reactance should be one-tenth the resistance of R2 at the unity-gain crossover frequency of the amplifier.

When an operational amplifier is operated open loop, it might appear at first glance that it needs no frequency compensation. However, this is not always the case because the external compensation is sometimes required to stabilize internal feedback loops.

The LM101 will not oscillate when operated open loop, although there may be problems if the capacitance between the balance terminal on pin 5 and the output is not held to an absolute minimum. Feedback between these two points is regenerative if it is not balanced out with a larger feedback capacitance across the compensation terminals. Usually a 3 pF compensation capacitor will completely eliminate the problem. The LM709 will oscillate when operated open loop unless a 10 pF capacitor is connected across the input compensation terminals and a 3 pF capacitor is connected on the output compensation terminals.

Problems encountered with supply bypassing are insidious in that they will hardly ever show up in a Nyquist plot. This problem has not really been thoroughly investigated, probably because one sure cure is known: bypass the positive and negative supply terminals of each amplifier to ground with at least a 0.01 μF capacitor.

For example, a LM101 can take over 1 mH inductance in either supply lead without oscillation. This should not suggest that they should be run without bypass capacitors. It has been established that 100 LM101's on a single printed circuit board with common supply busses will oscillate if the supplies are not bypassed about every fifth device. This happens even though the inputs and outputs are completely isolated.

The LM709, on the other hand, will oscillate under many load conditions with as little as 18 inches of wire between the negative supply lead and a bypass capacitor. Therefore, it is almost essential to have a set of bypass capacitors for every device.

Operational amplifiers are specified for power supply rejection at frequencies less than the first break frequency of the open loop gain. At higher frequencies, the rejection can be reduced depending on how the amplifier is frequency compensated. For both the LM101 and LM709, the rejection of high frequency signals on the positive supply is excellent. However, the situation is different for the negative supplies. These two amplifiers have compensation capacitors from the output down to a signal point which is referred to the negative supply, causing the high frequency rejection for the negative supply to be much reduced. It is therefore important to have sufficient bypassing on the negative supply to remove transients if they can cause trouble appearing on the output. One fairly large (22 μF) tantalum capacitor on the negative power lead for each printed-circuit card is usually enough to solve potential problems.

When high-current buffers are used in conjunction with operational amplifiers, supply bypassing and decoupling are even more important since they can feed a considerable amount of signal back into the supply lines. For reference, bypass capacitors of at least 0.1 μF are required for a 50 mA buffer.

When emitter followers are used to drive long cables, additional precautions are required. An emitter follower by it-

self—which is not contained in a feedback loop—will frequently oscillate when connected to a long length of cable. When an emitter follower is connected to the output of an operational amplifier, it can produce oscillations that will persist no matter how the loop gain is compensated. An analysis of why this happens is not very enlightening, so suffice it to say that these oscillations can usually be eliminated by putting a ferrite bead⁸ between the emitter follower and the cable.

Considering the loop gain of an amplifier is a valuable tool in understanding the influence of various factors on the stability of feedback amplifiers. But it is not too helpful in determining if the amplifier is indeed stable. The reason is that most problems in a well-designed system are caused by secondary effects—which occur only under certain conditions of output voltage, load current, capacitive loading, temperature, etc. Making frequency-phase plots under all these conditions would require unreasonable amounts of time, so it is invariably not done.

A better check on stability is the small-signal transient response. It can be shown mathematically that the transient response of a network has a one-for-one correspondence with the frequency domain response.[†] The advantage of transient response tests is that they are displayed instantaneously on an oscilloscope, so it is reasonable to test a circuit under a wide range of conditions.

Exact methods of analysis using transient response will not be presented here. This is not because these methods are difficult, although they are. Instead, it is because it is very easy to determine which conditions are unfavorable from the overshoot and ringing on the step response. The stability margin can be determined much more easily by how much greater the aggravating conditions can be made before the circuit oscillates than by analysis of the response under given conditions. A little practice with this technique can quickly yield much better results than classical methods even for the inexperienced engineer.

summary

A number of circuits using operational amplifiers have been proposed to show their versatility in circuit design. These have ranged from low frequency oscillators through circuits for complex analog computation. Because of the low cost of

monolithic amplifiers, it is almost foolish to design dc amplifiers without integrated circuits. Moreover, the price makes it practical to take advantage of operational-amplifier performance in a variety of circuits where they are not normally used.

Many of the potential oscillation problems that can be encountered in both discrete and integrated operational amplifiers were described, and some conservative solutions to these problems were presented. The areas discussed included stray capacitance, capacitive loading and supply bypassing. Finally, a simplified method of quickly testing the stability of amplifier circuits over a wide range of operating conditions was suggested.

[†]The frequency-domain characteristics can be determined from the impulse response of a network and this is directly relatable to the step response through the convolution integral.

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Application of the LH0002 Current Amplifier

National Semiconductor
Application Note 13



INTRODUCTION

The LH0002 Current Amplifier integrated building block provides a wide band unity gain amplifier capable of providing peak currents of up to ± 200 mA into a 50Ω load.

The circuit uses thick film technology to integrate 2 NPN and 2 PNP complementary matched silicon transistors with 4 cermet resistors on a single alumina ceramic substrate. A circuit schematic is shown in *Figure 1*. The negative thermal feedback provided by the close proximity of the components on a single substrate eliminates any thermal runaway problem that could occur if this circuit were constructed using discrete components.

A typical circuit features a dynamic input impedance of $200\text{ k}\Omega$, an output impedance of 6Ω , DC to 50 MHz bandwidth, and an output voltage swing that approaches supply voltage. A complete list of the guaranteed and typical values for the electrical characteristics under the stated conditions is given in Table I. These features make the LH0002 ideal for integration with an operational amplifier inside a closed loop configuration to increase its current output. The symmetrical class AB output portion of the circuit also provides a constant low output impedance for both the positive and negative slopes of output pulses.

CIRCUIT OPERATION

The majority of circuit applications will use symmetrical power supplies, with equal positive voltage being applied to pins 1 and 2, and equal negative voltage applied to pins 6 and 7.

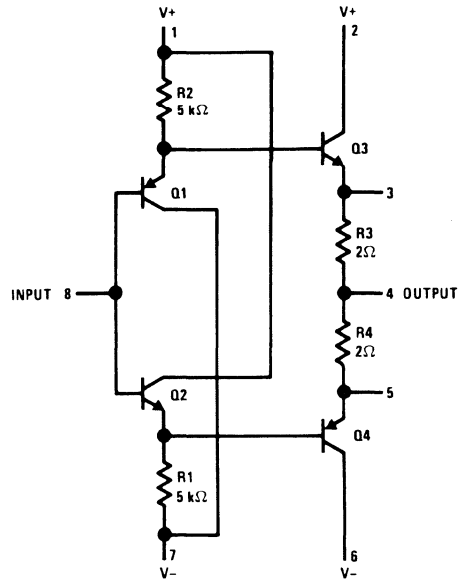


FIGURE 1. Circuit Schematic

TL/K/7315-1

TABLE I. Electrical characteristics, specification applies for $T_A = 25^\circ\text{C}$
with +12.0V on pins 1 and 2; -12.0V on pins 6 and 7.

Parameters	Conditions	Min	Typ	Max	Units
Voltage Gain	$R_S = 10\text{ k}\Omega$, $R_L = 1.0\text{ k}\Omega$ $V_{IN} = 3.0\text{ V}_{pp}$, $f = 1.0\text{ kHz}$ $T_A = 55^\circ\text{C}$ to 125°C	0.95	0.97		
Input Impedance	$R_S = 200\text{ k}\Omega$, $V_{IN} = 1.0\text{ V}_{rms}$, $f = 1.0\text{ kHz}$, $R_L = 1.0\text{ k}\Omega$	180	200	—	$\text{k}\Omega$
Output Impedance	$V_{IN} = 1.0\text{ V}_{rms}$, $f = 1.0\text{ kHz}$ $R_L = 50\Omega$, $R_S = 10\text{ k}\Omega$	—	6	10	Ω
Output Voltage Swing	$R_L = 1.0\text{ k}\Omega$, $f = 1.0\text{ kHz}$	± 10	± 11	—	V
DC Input Offset Voltage	$R_S = 10\text{ k}\Omega$, $R_L = 1.0\text{ k}\Omega$ $T_A = -55^\circ\text{C}$ to 125°C	—	± 40	± 100	mV
DC Input Offset Current	$R_S = 10\text{ k}\Omega$, $R_L = 1.0\text{ k}\Omega$ $T_A = -55^\circ\text{C}$ to 125°C	—	± 6.0	± 10	μA
Harmonic Distortion	$V_{IN} = 5.0\text{ V}_{rms}$, $f = 1.0\text{ kHz}$	—	0.1	—	%
Bandwidth	$V_{IN} = 1.0\text{ V}_{rms}$, $R_L = 50\Omega$ $R_S = 100\Omega$	30	50	—	MHz
Positive Supply Current	$R_S = 10\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$	—	+6.0	+10.0	mA
Negative Supply Current	$R_S = 10\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$	—	-6.0	-10.0	mA

The reason that pin 2 and pin 6 are not connected internally to pin 1 and pin 7, respectively, is to increase the versatility of circuit operation by allowing a decreased voltage to be applied to pins 2 and 6 to minimize the power dissipation in Q3 and Q4. The larger voltage applied to the input stage also provides increased current drive as required to the output stage.

The operation of the circuit can be understood by considering that the input pin 8 is at V_{IN} . The emitter of Q1 will be approximately 0.6V more positive than V_{IN} at 25°C, and the converse is true for Q2. This 0.6V will provide a forward bias on Q3 to cancel out the Q1 base to emitter drop which in turn would provide V_{IN} at the output if all junctions, resistors, power supplies, etc., were electrically identical. The greatest error is introduced because the forward drops in the base-emitter junctions for the NPN and PNP devices are slightly different. For example, the V_{BE} of the NPN will be typically 0.6V and the V_{BE} of the PNP will be typically 0.64V under the same conditions of $I_C = 2.4$ mA at $V_{CE} = 12.0$ V at 25°C. These are the approximate input stage circuit conditions for Q1 and Q2 for plus and minus 12V supplies. Fortunately, this error in both input and output offset voltage is almost always negligible when it is used inside the closed loop of a high gain operational amplifier.

A plot of input impedance vs frequency is shown in *Figure 2*. Inspection of this plot shows that the input impedance can be closely approximated to that of a simple first order linear network with a 45° phase lag at 0.6 MHz and a 90° phase lag at approximately one decade higher in frequency. This information is very useful for designers who have to integrate circuits which have large source impedances over a wide frequency range. The output impedance of the amplifier is very low, 6Ω typically, and in conjunction with a voltage bandwidth of approximately 50 MHz can be considered to be insignificant for most applications for this type of device.

A plot of the voltage bandwidth is shown in *Figure 3*. Inspection of this plot shows that phase information as well as gain information was included to assist users of this device. For example, at 10 MHz, less than an 8° phase lag would be subtracted from the phase margin of an operational amplifier when it is integrated with this device. The open loop gain of the operational amplifier would be decreased by less than 10% at 10 MHz and therefore can be considered to be insignificant for most applications.

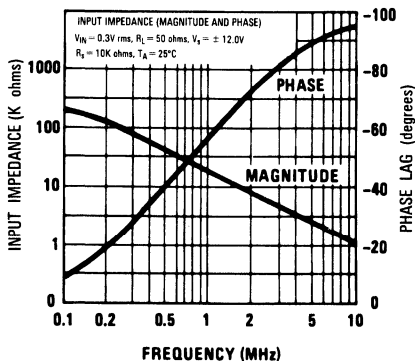


FIGURE 2. Input Impedance vs Frequency

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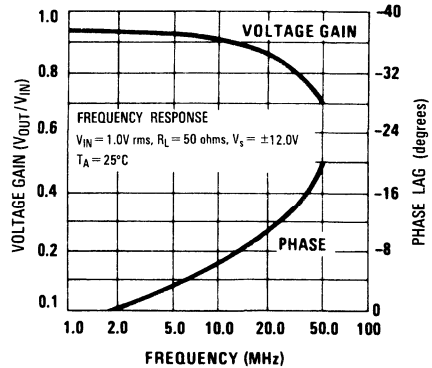


FIGURE 3. Frequency Response

TL/K/7315-3

APPLICATIONS

Figure 4 shows the LH0002 integrated with the LH0005 to provide differential inputs and outputs. In order for this circuit to function properly, a load must be floated between the outputs of the two devices to provide a complete loop of feedback. A differential head on a scope across the load presents a true waveform of the actual signal being applied to it. If only one end of the load is displayed, it will appear distorted because this information is being fed back negatively to the input in order to cancel out the loop distortion of the overall amplifier. With the compensation shown, a 20V peak to peak signal can be applied to a 100Ω load to 80 kHz. The overall circuit is approximately 33% efficient under these conditions. A derating factor and/or heat sink must be used at higher temperatures, as shown by the LH0002 and LH0005 data sheets.

Additional output power could also be obtained by connecting another LH0002 to pin 9 of the operational amplifier. The overall load distortion under high circuit voltage gain configurations would also be reduced using two LH0002's because the LH0002 is more linear than the simple output circuits of these particular operational amplifiers.

Figure 5 shows the LH0002 integrated with the LM101 in a booster follower configuration. The configuration is stable without the requirement for any external compensation; however, it would behoove the designer to be conservative and bypass both the negative and positive power supplies with at least a 0.01 μf capacitor to cancel out any power supply lead inductance. A 100Ω damping resistor, located right at the input of the LH0002, might also be required between the operational amplifier and the booster amplifier. The physical layout will determine the requirement for this type of oscillation suppression. Current limiting can be added by incorporating series resistors from pins 2 and 6 to their respective power supplies. The exact value would be a function of power supply voltage and required operating temperature.

A breadboard of this configuration was assembled to empirically check the increase in offset voltage due to the addition of the LH0002. The offset voltage was measured with and without an LH0002 inside the loop with a voltage gain of 100, at -55°C, 25°C and 125°C. The additional offset voltage was less than 0.3% for all three temperature conditions

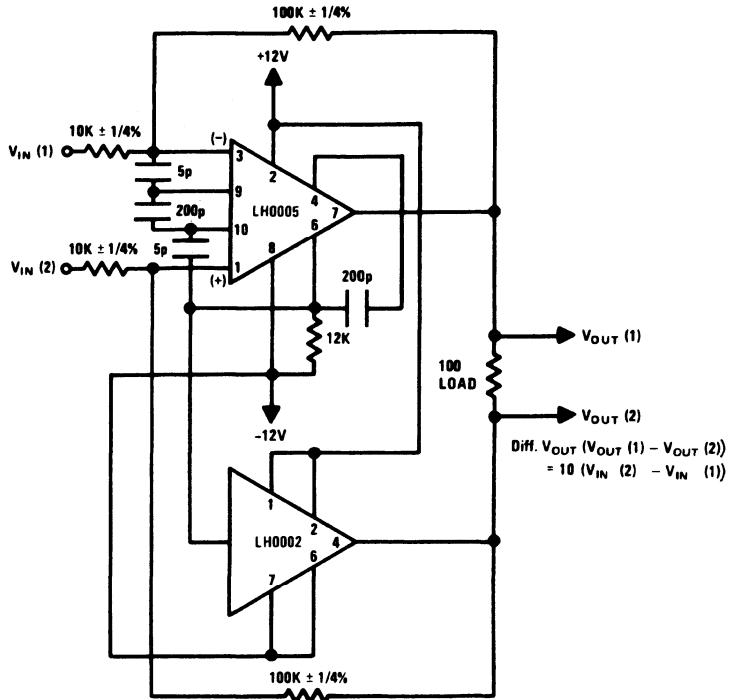


FIGURE 4. Differential Input-Output Operational Amplifier Integration

TL/K/7315-4

even though the offset voltage of the LH0002 is much higher than that of the LM101. The high open loop gain of the LM101 divides out this source of circuit error. The integration of this device also allows higher closed loop gain without excessive cross-over distortion than would be obtainable with the simple booster amplifier shown in Figure 6.

Figure 7 shows the LH0002 being used as a level shifter with a high pass filter on the input in order to reference the output to zero quiescent volts. The purpose of the 10 kΩ resistor is to provide current bias to the circuit's input transistors to reduce the output offset voltage. Figure 3, Input

Impedance vs Frequency, provides a useful design aid in order to determine the value of the capacitor for the particular application. The 10 kΩ resistor, of course, has to be considered as being in parallel with the circuit's input impedance.

For a pulse input signal, the output impedance of the circuit remains low for both the positive and negative portions of the output pulse. This circuit provides both fast rise and fall times for pulse signals, even with capacitive loading. The LH0002 data sheet shows typical rise and fall times for both positive and negative pulses into a 50Ω load.

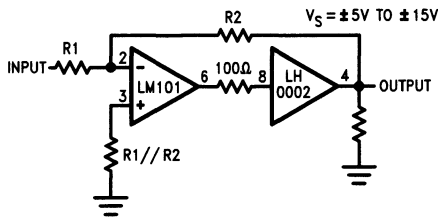


FIGURE 5. LM101-LH0002 Booster Amplifier Integration

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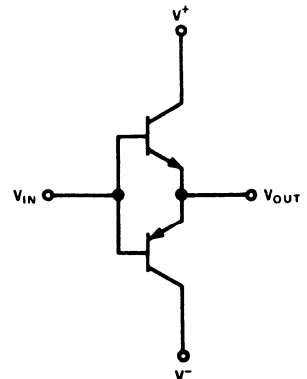


FIGURE 6. Simple Booster Amplifier

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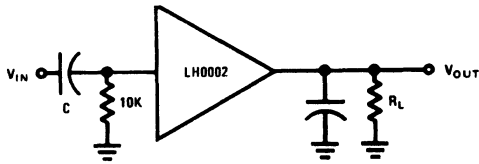


FIGURE 7. Level Shifter

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Figure 8 shows the LH0002 being used to drive a pulse-transformer. The low output offset voltage allows the pulse transformer to be directly coupled to the amplifier without using a coupling capacitor to prevent saturation. The pulse transformer can be used to change the amplitude and im-

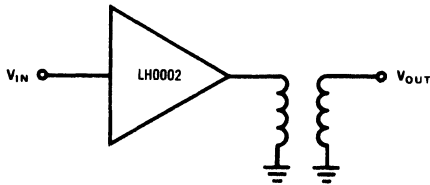


FIGURE 8. Driver for a Pulse-Transformer

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pedance level of the pulse, the polarity of the pulses, or, with the aid of a center-tapped winding, positive and negative pulses simultaneously.

The LH0002 can also be used to drive long transmission lines. Figure 9 shows a circuit configuration to match the output impedance of the amplifier to the load and coaxial cable for proper line termination to minimize reflections. A capacitor can be added to empirically adjust the time response of the waveform.

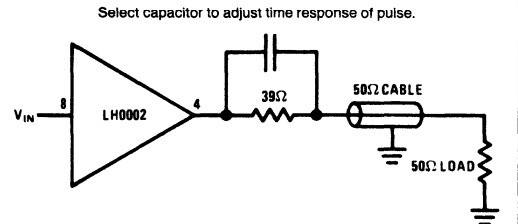


FIGURE 9. Transmission Line Driver

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SUMMARY

The multitude of different applications suggested in this article shows the versatility of the LH0002. The applications specially covered were for a differential input-output operational amplifier, booster amplifier, level shifter, driver for a pulse-transformer, and transmission line driver.

An Applications Guide for Op Amps

National Semiconductor
Application Note 20



INTRODUCTION

The general utility of the operational amplifier is derived from the fact that it is intended for use in a feedback loop whose feedback properties determine the feed-forward characteristics of the amplifier and loop combination. To suit it for this usage, the ideal operational amplifier would have infinite input impedance, zero output impedance, infinite gain and an open-loop 3 dB point at infinite frequency rolling off at 6 dB per octave. Unfortunately, the unit cost—in quantity—would also be infinite.

Intensive development of the operational amplifier, particularly in integrated form, has yielded circuits which are quite good engineering approximations of the ideal for finite cost. Quantity prices for the best contemporary integrated amplifiers are low compared with transistor prices of five years ago. The low cost and high quality of these amplifiers allows the implementation of equipment and systems functions impractical with discrete components. An example is the low frequency function generator which may use 15 to 20 operational amplifiers in generation, wave shaping, triggering and phase-locking.

The availability of the low-cost integrated amplifier makes it mandatory that systems and equipments engineers be familiar with operational amplifier applications. This paper will present amplifier usages ranging from the simple unity-gain buffer to relatively complex generator and wave shaping circuits. The general theory of operational amplifiers is not within the scope of this paper and many excellent references are available in the literature.^{1,2,3,4} The approach will be shaded toward the practical, amplifier parameters will be discussed as they affect circuit performance, and application restrictions will be outlined.

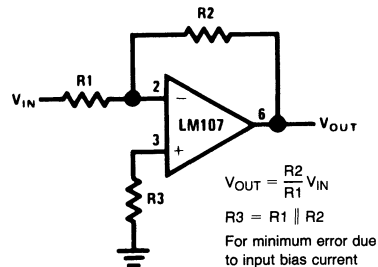
The applications discussed will be arranged in order of increasing complexity in five categories: simple amplifiers, operational circuits, transducer amplifiers, wave shapers and generators, and power supplies. The integrated amplifiers shown in the figures are for the most part internally compen-

sated so frequency stabilization components are not shown; however, other amplifiers may be used to achieve greater operating speed in many circuits as will be shown in the text. Amplifier parameter definitions are contained in Appendix I.

THE INVERTING AMPLIFIER

The basic operational amplifier circuit is shown in *Figure 1*. This circuit gives closed-loop gain of R_2/R_1 when this ratio is small compared with the amplifier open-loop gain and, as the name implies, is an inverting circuit. The input impedance is equal to R_1 . The closed-loop bandwidth is equal to the unity-gain frequency divided by one plus the closed-loop gain.

The only cautions to be observed are that R_3 should be chosen to be equal to the parallel combination of R_1 and R_2 to minimize the offset voltage error due to bias current and that there will be an offset voltage at the amplifier output equal to closed-loop gain times the offset voltage at the amplifier input.



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FIGURE 1. Inverting Amplifier

Offset voltage at the input of an operational amplifier is comprised of two components, these components are identified in specifying the amplifier as input offset voltage and input bias current. The input offset voltage is fixed for a particular amplifier, however the contribution due to input

bias current is dependent on the circuit configuration used. For minimum offset voltage at the amplifier input without circuit adjustment the source resistance for both inputs should be equal. In this case the maximum offset voltage would be the algebraic sum of amplifier offset voltage and the voltage drop across the source resistance due to offset current. Amplifier offset voltage is the predominant error term for low source resistances and offset current causes the main error for high source resistances.

In high source resistance applications, offset voltage at the amplifier output may be adjusted by adjusting the value of R3 and using the variation in voltage drop across it as an input offset voltage trim.

Offset voltage at the amplifier output is not as important in AC coupled applications. Here the only consideration is that any offset voltage at the output reduces the peak to peak linear output swing of the amplifier.

The gain-frequency characteristic of the amplifier and its feedback network must be such that oscillation does not occur. To meet this condition, the phase shift through amplifier and feedback network must never exceed 180° for any frequency where the gain of the amplifier and its feedback network is greater than unity. In practical applications, the phase shift should not approach 180° since this is the situation of conditional stability. Obviously the most critical case occurs when the attenuation of the feedback network is zero.

Amplifiers which are not internally compensated may be used to achieve increased performance in circuits where feedback network attenuation is high. As an example, the LM101 may be operated at unity gain in the inverting amplifier circuit with a 15 pF compensating capacitor, since the feedback network has an attenuation of 6 dB, while it requires 30 pF in the non-inverting unity gain connection where the feedback network has zero attenuation. Since amplifier slew rate is dependent on compensation, the LM101 slew rate in the inverting unity gain connection will be twice that for the non-inverting connection and the inverting gain of ten connection will yield eleven times the slew rate of the non-inverting unity gain connection. The compensation trade-off for a particular connection is stability versus bandwidth, larger values of compensation capacitor yield greater stability and lower bandwidth and vice versa.

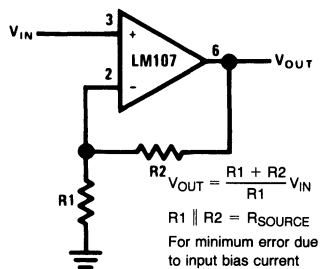
The preceding discussion of offset voltage, bias current and stability is applicable to most amplifier applications and will be referenced in later sections. A more complete treatment is contained in Reference 4.

THE NON-INVERTING AMPLIFIER

Figure 2 shows a high input impedance non-inverting circuit. This circuit gives a closed-loop gain equal to the ratio of the sum of R1 and R2 to R1 and a closed-loop 3 dB bandwidth equal to the amplifier unity-gain frequency divided by the closed-loop gain.

The primary differences between this connection and the inverting circuit are that the output is not inverted and that the input impedance is very high and is equal to the differential input impedance multiplied by loop gain. (Open loop gain/Closed loop gain.) In DC coupled applications, input impedance is not as important as input current and its voltage drop across the source resistance.

Applications cautions are the same for this amplifier as for the inverting amplifier with one exception. The amplifier output will go into saturation if the input is allowed to float. This may be important if the amplifier must be switched from source to source. The compensation trade off discussed for the inverting amplifier is also valid for this connection.

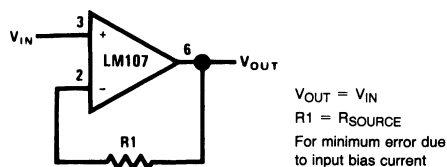


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FIGURE 2. Non-Inverting Amplifier

THE UNITY-GAIN BUFFER

The unity-gain buffer is shown in Figure 3. The circuit gives the highest input impedance of any operational amplifier circuit. Input impedance is equal to the differential input impedance multiplied by the open-loop gain, in parallel with common mode input impedance. The gain error of this circuit is equal to the reciprocal of the amplifier open-loop gain or to the common mode rejection, whichever is less.



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FIGURE 3. Unity Gain Buffer

Input impedance is a misleading concept in a DC coupled unity-gain buffer. Bias current for the amplifier will be supplied by the source resistance and will cause an error at the amplifier input due to its voltage drop across the source resistance. Since this is the case, a low bias current amplifier such as the LM102⁶ should be chosen as a unity-gain buffer when working from high source resistances. Bias current compensation techniques are discussed in Reference 5.

The cautions to be observed in applying this circuit are three: the amplifier must be compensated for unity gain operation, the output swing of the amplifier may be limited by the amplifier common mode range, and some amplifiers exhibit a latch-up mode when the amplifier common mode range is exceeded. The LM107 may be used in this circuit with none of these problems; or, for faster operation, the LM102 may be chosen.

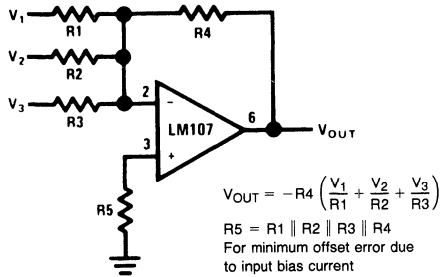


FIGURE 4. Summing Amplifier

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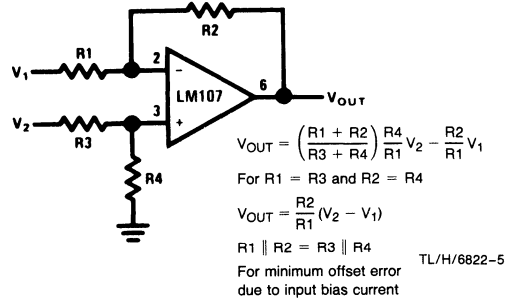
SUMMING AMPLIFIER

The summing amplifier, a special case of the inverting amplifier, is shown in *Figure 4*. The circuit gives an inverted output which is equal to the weighted algebraic sum of all three inputs. The gain of any input of this circuit is equal to the ratio of the appropriate input resistor to the feedback resistor, R4. Amplifier bandwidth may be calculated as in the inverting amplifier shown in *Figure 1* by assuming the input resistor to be the parallel combination of R1, R2, and R3. Application cautions are the same as for the inverting amplifier. If an uncompensated amplifier is used, compensation is calculated on the basis of this bandwidth as is discussed in the section describing the simple inverting amplifier.

The advantage of this circuit is that there is no interaction between inputs and operations such as summing and weighted averaging are implemented very easily.

THE DIFFERENCE AMPLIFIER

The difference amplifier is the complement of the summing amplifier and allows the subtraction of two voltages or, as a special case, the cancellation of a signal common to the two inputs. This circuit is shown in *Figure 5* and is useful as a computational amplifier, in making a differential to single-ended conversion or in rejecting a common mode signal.



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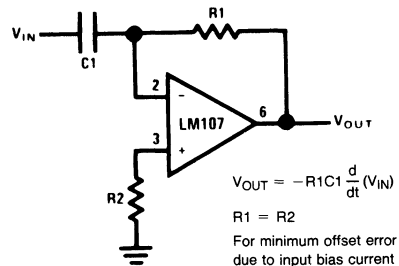
FIGURE 5. Difference Amplifier

Circuit bandwidth may be calculated in the same manner as for the inverting amplifier, but input impedance is somewhat more complicated. Input impedance for the two inputs is not necessarily equal; inverting input impedance is the same as for the inverting amplifier of *Figure 1* and the non-inverting input impedance is the sum of R3 and R4. Gain for either input is the ratio of R1 to R2 for the special case of a differential input single-ended output where $R_1 = R_3$ and $R_2 = R_4$. The general expression for gain is given in the figure. Compensation should be chosen on the basis of amplifier bandwidth.

Care must be exercised in applying this circuit since input impedances are not equal for minimum bias current error.

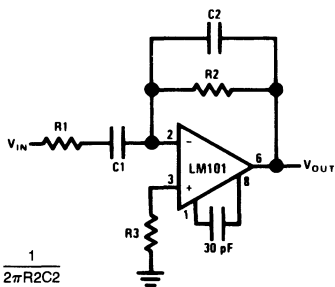
DIFFERENTIATOR

The differentiator is shown in *Figure 6* and, as the name implies, is used to perform the mathematical operation of differentiation. The form shown is not the practical form, it is a true differentiator and is extremely susceptible to high frequency noise since AC gain increases at the rate of 6 dB per octave. In addition, the feedback network of the differentiator, R_1C_1 , is an RC low pass filter which contributes 90° phase shift to the loop and may cause stability problems even with an amplifier which is compensated for unity gain.



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FIGURE 6. Differentiator



$$f_c = \frac{1}{2\pi R_2 C_1}$$

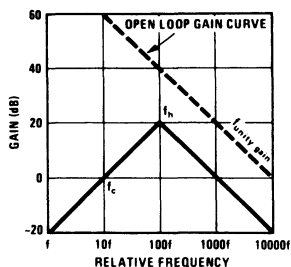
$$f_h = \frac{1}{2\pi R_1 C_1} = \frac{1}{2\pi R_2 C_2}$$

$$f_c \ll f_h \ll f_{\text{unity gain}}$$

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FIGURE 7. Practical Differentiator

A practical differentiator is shown in Figure 7. Here both the stability and noise problems are corrected by addition of two additional components, R1 and C2. R2 and C2 form a 6 dB per octave high frequency roll-off in the feedback network and R1C1 form a 6 dB per octave roll-off network in the input network for a total high frequency roll-off of 12 dB per octave to reduce the effect of high frequency input and amplifier noise. In addition R1C1 and R2C2 form lead networks in the feedback loop which, if placed below the amplifier unity gain frequency, provide 90° phase lead to compensate the 90° phase lag of R2C1 and prevent loop instability. A gain frequency plot is shown in Figure 8 for clarity.

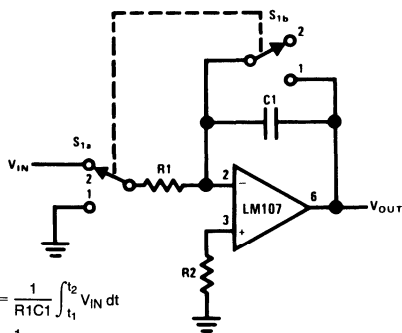


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FIGURE 8. Differentiator Frequency Response

INTEGRATOR

The integrator is shown in Figure 9 and performs the mathematical operation of integration. This circuit is essentially



$$V_{OUT} = \frac{1}{R_1 C_1} \int_{t_1}^{t_2} V_{IN} dt$$

$$f_c = \frac{1}{2\pi R_1 C_1}$$

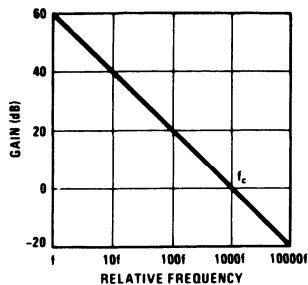
$$R_1 = R_2$$

For minimum offset error due to input bias current

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FIGURE 9. Integrator

a low-pass filter with a frequency response decreasing at 6 dB per octave. An amplitude-frequency plot is shown in Figure 10.



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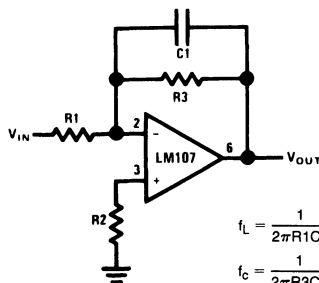
FIGURE 10. Integrator Frequency Response

The circuit must be provided with an external method of establishing initial conditions. This is shown in the figure as S1. When S1 is in position 1, the amplifier is connected in unity-gain and capacitor C1 is discharged, setting an initial condition of zero volts. When S1 is in position 2, the amplifier is connected as an integrator and its output will change in accordance with a constant times the time integral of the input voltage.

The cautions to be observed with this circuit are two: the amplifier used should generally be stabilized for unity-gain operation and R2 must equal R1 for minimum error due to bias current.

SIMPLE LOW-PASS FILTER

The simple low-pass filter is shown in Figure 11. This circuit has a 6 dB per octave roll-off after a closed-loop 3 dB point defined by fc. Gain below this corner frequency is defined by the ratio of R3 to R1. The circuit may be considered as an AC integrator at frequencies well above fc; however, the time domain response is that of a single RC rather than an integral.



$$f_L = \frac{1}{2\pi R_1 C_1}$$

$$f_c = \frac{1}{2\pi R_3 C_1}$$

$$A_L = \frac{R_3}{R_1}$$

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FIGURE 11. Simple Low Pass Filter

R2 should be chosen equal to the parallel combination of R1 and R3 to minimize errors due to bias current. The amplifier should be compensated for unity-gain or an internally compensated amplifier can be used.

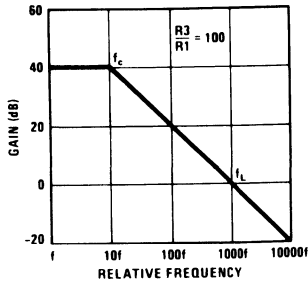


FIGURE 12. Low Pass Filter Response

A gain frequency plot of circuit response is shown in *Figure 12* to illustrate the difference between this circuit and the true integrator.

THE CURRENT-TO-VOLTAGE CONVERTER

Current may be measured in two ways with an operational amplifier. The current may be converted into a voltage with a resistor and then amplified or the current may be injected directly into a summing node. Converting into voltage is undesirable for two reasons: first, an impedance is inserted into the measuring line causing an error; second, amplifier offset voltage is also amplified with a subsequent loss of accuracy. The use of a current-to-voltage transducer avoids both of these problems.

The current-to-voltage transducer is shown in *Figure 13*. The input current is fed directly into the summing node and the amplifier output voltage changes to extract the same current from the summing node through R_1 . The scale factor of this circuit is R_1 volts per amp. The only conversion error in this circuit is I_{bias} which is summed algebraically with I_{IN} .

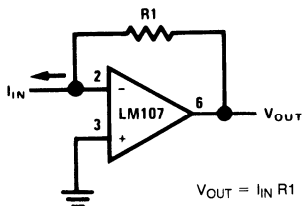


FIGURE 13. Current to Voltage Converter

This basic circuit is useful for many applications other than current measurement. It is shown as a photocell amplifier in the following section.

The only design constraints are that scale factors must be chosen to minimize errors due to bias current and since voltage gain and source impedance are often indeterminate (as with photocells) the amplifier must be compensated for unity-gain operation. Valuable techniques for bias current compensation are contained in Reference 5.

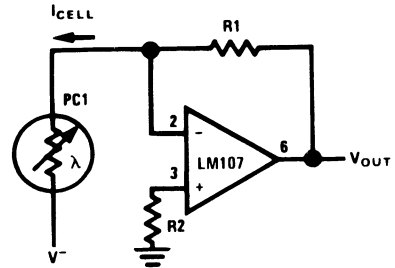


FIGURE 14. Amplifier for Photoconductive Cell

PHOTOCELL AMPLIFIERS

Amplifiers for photoconductive, photodiode and photovoltaic cells are shown in *Figures 14, 15 and 16* respectively.

All photogenerators display some voltage dependence of both speed and linearity. It is obvious that the current through a photoconductive cell will not display strict proportionality to incident light if the cell terminal voltage is allowed to vary with cell conductance. Somewhat less obvious is the fact that photodiode leakage and photovoltaic cell internal losses are also functions of terminal voltage. The current-to-voltage converter neatly sidesteps gross linearity problems by fixing a constant terminal voltage, zero in the case of photovoltaic cells and a fixed bias voltage in the case of photoconductors or photodiodes.

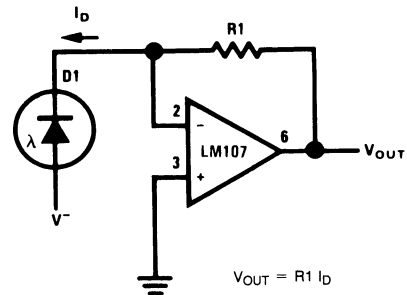


FIGURE 15. Photodiode Amplifier

Photodetector speed is optimized by operating into a fixed low load impedance. Currently available photovoltaic detectors show response times in the microsecond range at zero load impedance and photoconductors, even though slow, are materially faster at low load resistances.

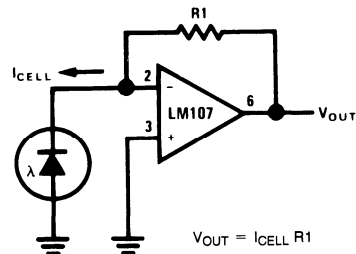
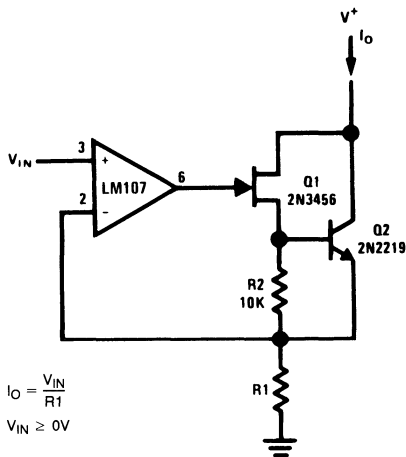


FIGURE 16. Photovoltaic Cell Amplifier

The feedback resistance, R1, is dependent on cell sensitivity and should be chosen for either maximum dynamic range or for a desired scale factor. R2 is elective: in the case of photovoltaic cells or of photodiodes, it is not required in the case of photoconductive cells, it should be chosen to minimize bias current error over the operating range.

PRECISION CURRENT SOURCE

The precision current source is shown in *Figures 17 and 18*. The configurations shown will sink or source conventional current respectively.



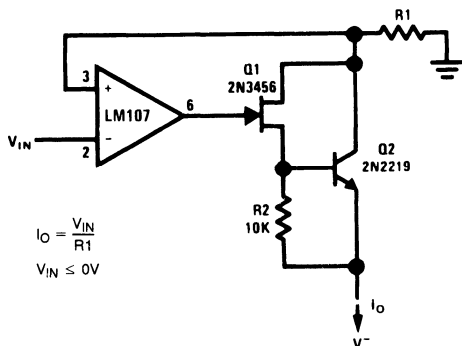
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FIGURE 17. Precision Current Sink

Caution must be exercised in applying these circuits. The voltage compliance of the source extends from BV_{CER} of the external transistor to approximately 1 volt more negative than V_{IN} . The compliance of the current sink is the same in the positive direction.

The impedance of these current generators is essentially infinite for small currents and they are accurate so long as V_{IN} is much greater than V_{OS} and I_O is much greater than I_{bias} .

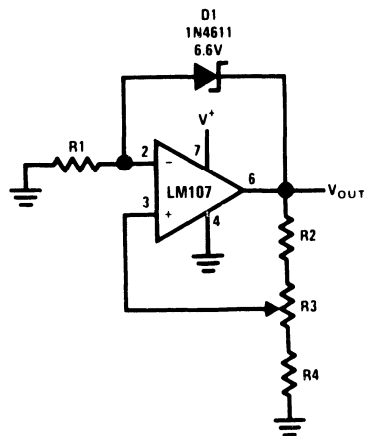
The source and sink illustrated in *Figures 17 and 18* use an FET to drive a bipolar output transistor. It is possible to use a Darlington connection in place of the FET-bipolar combination in cases where the output current is high and the base current of the Darlington input would not cause a significant error.



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FIGURE 18. Precision Current Source

The amplifiers used must be compensated for unity-gain and additional compensation may be required depending on load reactance and external transistor parameters.

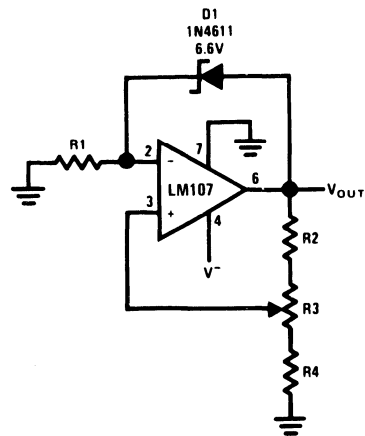


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FIGURE 19a. Positive Voltage Reference

ADJUSTABLE VOLTAGE REFERENCES

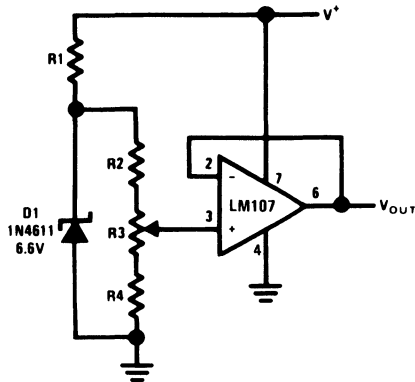
Adjustable voltage reference circuits are shown in *Figures 19 and 20*. The two circuits shown have different areas of applicability. The basic difference between the two is that *Figure 19* illustrates a voltage source which provides a voltage greater than the reference diode while *Figure 20* illustrates a voltage source which provides a voltage lower than the reference diode. The figures show both positive and negative voltage sources.



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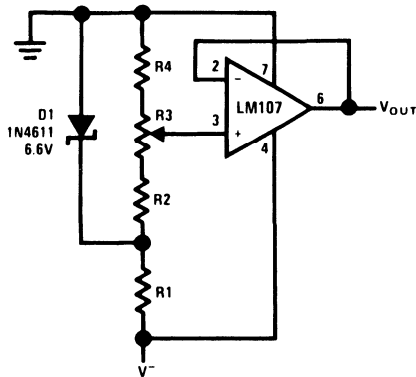
FIGURE 19b. Negative Voltage Reference

High precision extended temperature applications of the circuit of *Figure 19* require that the range of adjustment of V_{OUT} be restricted. When this is done, R1 may be chosen to provide optimum zener current for minimum zener T.C. Since I_Z is not a function of V^+ , reference T.C. will be independent of V^+ .



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FIGURE 20a. Positive Voltage Reference



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FIGURE 20b. Negative Voltage Reference

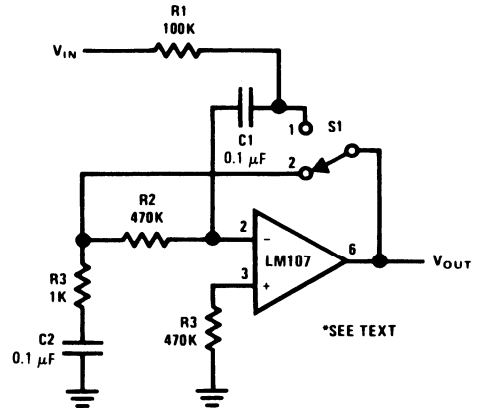
The circuit of Figure 20 is suited for high precision extended temperature service if V^+ is reasonably constant since I_Z is dependent on V^+ . R_1 , R_2 , R_3 , and R_4 are chosen to provide the proper I_Z for minimum T.C. and to minimize errors due to I_{bias} .

The circuits shown should both be compensated for unity-gain operation or, if large capacitive loads are expected, should be overcompensated. Output noise may be reduced in both circuits by bypassing the amplifier input.

The circuits shown employ a single power supply, this requires that common mode range be considered in choosing an amplifier for these applications. If the common mode range requirements are in excess of the capability of the amplifier, two power supplies may be used. The LM101 may be used with a single power supply since the common mode range is from V^+ to within approximately 2 volts of V^- .

THE RESET STABILIZED AMPLIFIER

The reset stabilized amplifier is a form of chopper-stabilized amplifier and is shown in Figure 21. As shown, the amplifier is operated closed-loop with a gain of one.



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FIGURE 21. Reset Stabilized Amplifier

The connection is useful in eliminating errors due to offset voltage and bias current. The output of this circuit is a pulse whose amplitude is equal to V_{IN} . Operation may be understood by considering the two conditions corresponding to the position of S_1 . When S_1 is in position 2, the amplifier is connected in the unity gain connection and the voltage at the output will be equal to the sum of the input offset voltage and the drop across R_2 due to input bias current. The voltage at the inverting input will be equal to input offset voltage. Capacitor C_1 will charge to the sum of input offset voltage and V_{IN} through R_1 . When C_1 is charged, no current flows through the source resistance and R_1 so there is no error due to input resistance. S_1 is then changed to position 1. The voltage stored on C_1 is inserted between the output and inverting input of the amplifier and the output of the amplifier changes by V_{IN} to maintain the amplifier input at the input offset voltage. The output then changes from $(V_{OS} + I_{bias}R_2)$ to $(V_{IN} + I_{bias}R_2)$ as S_1 is changed from position 2 to position 1. Amplifier bias current is supplied through R_2 from the output of the amplifier or from C_2 when S_1 is in position 2 and position 1 respectively. R_3 serves to reduce the offset at the amplifier output if the amplifier must have maximum linear range or if it is desired to DC couple the amplifier.

An additional advantage of this connection is that input resistance approaches infinity as the capacitor C_1 approaches full charge, eliminating errors due to loading of the source resistance. The time spent in position 2 should be long with respect to the charging time of C_1 for maximum accuracy.

The amplifier used must be compensated for unity gain operation and it may be necessary to overcompensate because of the phase shift across R_2 due to C_1 and the amplifier input capacity. Since this connection is usually used at very low switching speeds, slew rate is not normally a practical consideration and overcompensation does not reduce accuracy.

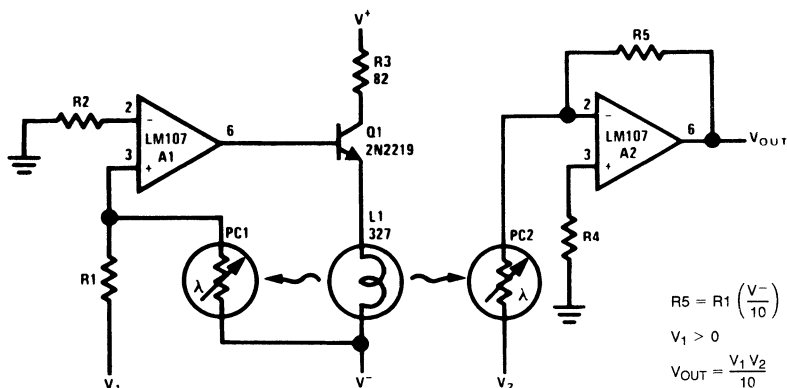


FIGURE 22. Analog Multiplier

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THE ANALOG MULTIPLIER

A simple embodiment of the analog multiplier is shown in *Figure 22*. This circuit circumvents many of the problems associated with the log-antilog circuit and provides three quadrant analog multiplication which is relatively temperature insensitive and which is not subject to the bias current errors which plague most multipliers.

Circuit operation may be understood by considering A2 as a controlled gain amplifier, amplifying V_2 , whose gain is dependent on the ratio of the resistance of PC2 to R5 and by considering A1 as a control amplifier which establishes the resistance of PC2 as a function of V_1 . In this way it is seen that V_{OUT} is a function of both V_1 and V_2 .

A1, the control amplifier, provides drive for the lamp, L1. When an input voltage, V_1 , is present, L1 is driven by A1 until the current to the summing junction from the negative supply through PC1 is equal to the current to the summing junction from V_1 through R1. Since the negative supply voltage is fixed, this forces the resistance of PC1 to a value proportional to R1 and to the ratio of V_1 to V^- . L1 also illuminates PC2 and, if the photoconductors are matched, causes PC2 to have a resistance equal to PC1.

A2, the controlled gain amplifier, acts as an inverting amplifier whose gain is equal to the ratio of the resistance of PC2 to R5. If R5 is chosen equal to the product of R1 and V^- , then V_{OUT} becomes simply the product of V_1 and V_2 . R5 may be scaled in powers of ten to provide any required output scale factor.

PC1 and PC2 should be matched for best tracking over temperature since the T.C. of resistance is related to resistance match for cells of the same geometry. Small mismatches may be compensated by varying the value of R5 as a scale factor adjustment. The photoconductive cells should receive equal illumination from L1, a convenient method is to

mount the cells in holes in an aluminum block and to mount the lamp midway between them. This mounting method provides controlled spacing and also provides a thermal bridge between the two cells to reduce differences in cell temperature. This technique may be extended to the use of FET's or other devices to meet special resistance or environment requirements.

The circuit as shown gives an inverting output whose magnitude is equal to one-tenth the product of the two analog inputs. Input V_1 is restricted to positive values, but V_2 may assume both positive and negative values. This circuit is restricted to low frequency operation by the lamp time constant.

R2 and R4 are chosen to minimize errors due to input offset current as outlined in the section describing the photocell amplifier. R3 is included to reduce in-rush current when first turning on the lamp, L1.

THE FULL-WAVE RECTIFIER AND AVERAGING FILTER

The circuit shown in *Figure 23* is the heart of an average reading, rms calibrated AC voltmeter. As shown, it is a rectifier and averaging filter. Deletion of C2 removes the averaging function and provides a precision full-wave rectifier, and deletion of C1 provides an absolute value generator.

Circuit operation may be understood by following the signal path for negative and then for positive inputs. For negative signals, the output of amplifier A1 is clamped to +0.7V by D1 and disconnected from the summing point of A2 by D2. A2 then functions as a simple unity-gain inverter with input resistor, R1, and feedback resistor, R2, giving a positive going output.

For positive inputs, A1 operates as a normal amplifier connected to the A2 summing point through resistor, R5. Amplifier A1 then acts as a simple unity-gain inverter with input

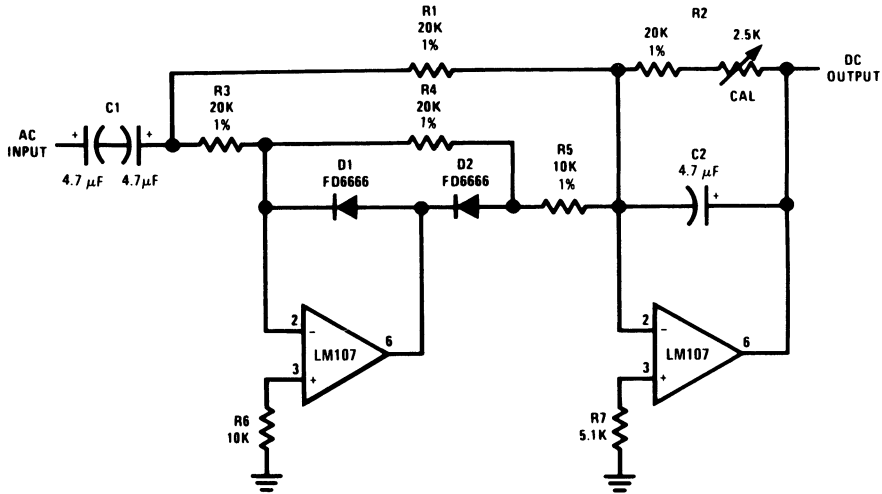


FIGURE 23. Full-Wave Rectifier and Averaging Filter

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resistor, R3, and feedback resistor, R5. A1 gain accuracy is not affected by D2 since it is inside the feedback loop. Positive current enters the A2 summing point through resistor, R1, and negative current is drawn from the A2 summing point through resistor, R5. Since the voltages across R1 and R5 are equal and opposite, and R5 is one-half the value of R1, the net input current at the A2 summing point is equal to and opposite from the current through R1 and amplifier A2 operates as a summing inverter with unity gain, again giving a positive output.

The circuit becomes an averaging filter when C2 is connected across R2. Operation of A2 then is similar to the Simple Low Pass Filter previously described. The time constant R_2C_2 should be chosen to be much larger than the maximum period of the input voltage which is to be averaged.

Capacitor C1 may be deleted if the circuit is to be used as an absolute value generator. When this is done, the circuit output will be the positive absolute value of the input voltage.

The amplifiers chosen must be compensated for unity-gain operation and R6 and R7 must be chosen to minimize output errors due to input offset current.

SINE WAVE OSCILLATOR

An amplitude-stabilized sine-wave oscillator is shown in Figure 24. This circuit provides high purity sine-wave output down to low frequencies with minimum circuit complexity. An important advantage of this circuit is that the traditional tungsten filament lamp amplitude regulator is eliminated along with its time constant and linearity problems.

In addition, the reliability problems associated with a lamp are eliminated.

The Wien Bridge oscillator is widely used and takes advantage of the fact that the phase of the voltage across the parallel branch of a series and a parallel RC network connected in series, is the same as the phase of the applied voltage across the two networks at one particular frequency and that the phase lags with increasing frequency and leads

with decreasing frequency. When this network—the Wien Bridge—is used as a positive feedback element around an amplifier, oscillation occurs at the frequency at which the phase shift is zero. Additional negative feedback is provided to set loop gain to unity at the oscillation frequency. To stabilize the frequency of oscillation, and to reduce harmonic distortion.

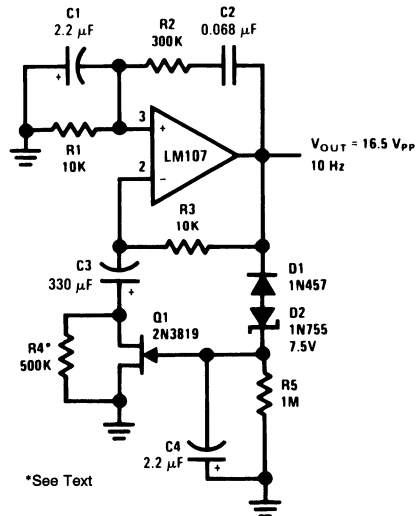


FIGURE 24. Wien Bridge Sine Wave Oscillator

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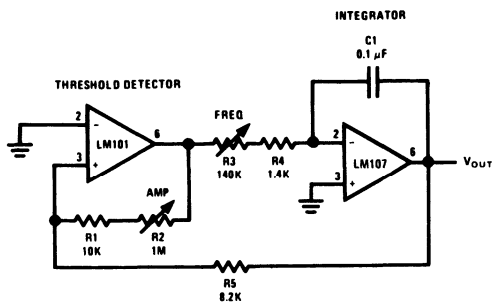
The circuit presented here differs from the classic usage only in the form of the negative feedback stabilization scheme. Circuit operation is as follows: negative peaks in excess of $-8.25V$ cause D1 and D2 to conduct, charging

C4. The charge stored in C4 provides bias to Q1, which determines amplifier gain. C3 is a low frequency roll-off capacitor in the feedback network and prevents offset voltage and offset current errors from being multiplied by amplifier gain.

Distortion is determined by amplifier open-loop gain and by the response time of the negative feedback loop filter, R5 and C4. A trade-off is necessary in determining amplitude stabilization time constant and oscillator distortion. R4 is chosen to adjust the negative feedback loop so that the FET is operated at a small negative gate bias. The circuit shown provides optimum values for a general purpose oscillator.

TRIANGLE-WAVE GENERATOR

A constant amplitude triangular-wave generator is shown in Figure 25. This circuit provides a variable frequency triangular wave whose amplitude is independent of frequency.



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FIGURE 25. Triangular-Wave Generator

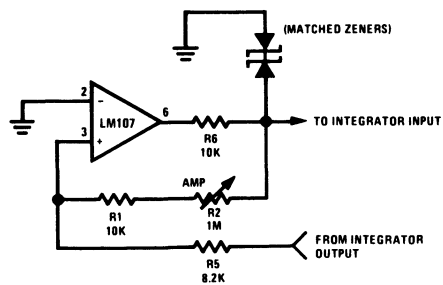
The generator embodies an integrator as a ramp generator and a threshold detector with hysteresis as a reset circuit. The integrator has been described in a previous section and requires no further explanation. The threshold detector is similar to a Schmitt Trigger in that it is a latch circuit with a large dead zone. This function is implemented by using positive feedback around an operational amplifier. When the amplifier output is in either the positive or negative saturated state, the positive feedback network provides a voltage at the non-inverting input which is determined by the attenuation of the feedback loop and the saturation voltage of the amplifier. To cause the amplifier to change states, the voltage at the input of the amplifier must be caused to change polarity by an amount in excess of the amplifier input offset voltage. When this is done the amplifier saturates in the opposite direction and remains in that state until the voltage at its input again reverses. The complete circuit operation may be understood by examining the operation with the output of the threshold detector in the positive state. The detector positive saturation voltage is applied to the integrator summing junction through the combination R3 and R4 causing a current I^+ to flow.

The integrator then generates a negative-going ramp with a rate of $I^+/C1$ volts per second until its output equals the negative trip point of the threshold detector. The threshold detector then changes to the negative output state and supplies a negative current, I^- , at the integrator summing point. The integrator now generates a positive-going ramp with a rate of $I^-/C1$ volts per second until its output equals the positive trip point of the threshold detector where the detector again changes output state and the cycle repeats.

Triangular-wave frequency is determined by R3, R4 and C1 and the positive and negative saturation voltages of the amplifier A1. Amplitude is determined by the ratio of R5 to the combination of R1 and R2 and the threshold detector saturation voltages. Positive and negative ramp rates are equal and positive and negative peaks are equal if the detector has equal positive and negative saturation voltages. The output waveform may be offset with respect to ground if the inverting input of the threshold detector, A1, is offset with respect to ground.

The generator may be made independent of temperature and supply voltage if the detector is clamped with matched zener diodes as shown in Figure 26.

The integrator should be compensated for unity-gain and the detector may be compensated if power supply impedance causes oscillation during its transition time. The current into the integrator should be large with respect to I_{bias} for maximum symmetry, and offset voltage should be small with respect to V_{OUT} peak.



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FIGURE 26. Threshold Detector with Regulated Output

TRACKING REGULATED POWER SUPPLY

A tracking regulated power supply is shown in Figure 27. This supply is very suitable for powering an operational amplifier system since positive and negative voltages track, eliminating common mode signals originating in the supply voltage. In addition, only one voltage reference and a minimum number of passive components are required.

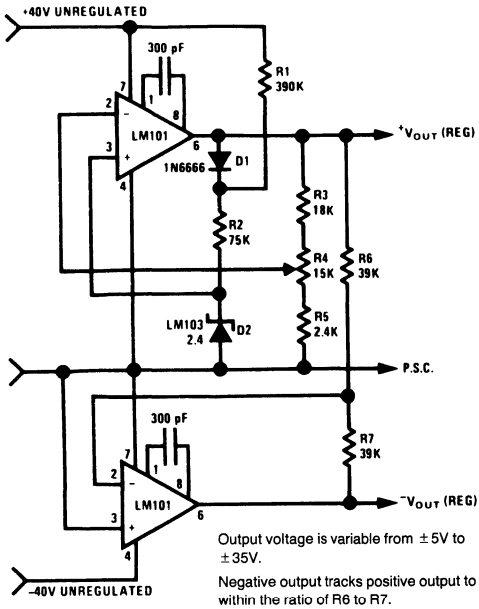


FIGURE 27. Tracking Power Supply

Power supply operation may be understood by considering first the positive regulator. The positive regulator compares the voltage at the wiper of R4 to the voltage reference, D2. The difference between these two voltages is the input voltage for the amplifier and since R3, R4, and R5 form a negative feedback loop, the amplifier output voltage changes in such a way as to minimize this difference. The voltage reference current is supplied from the amplifier output to increase power supply line regulation. This allows the regulator to operate from supplies with large ripple voltages. Regulating the reference current in this way requires a separate source of current for supply start-up. Resistor R1 and diode D1 provide this start-up current. D1 decouples the reference string from the amplifier output during start-up and R1 supplies the start-up current from the unregulated positive supply. After start-up, the low amplifier output impedance reduces reference current variations due to the current through R1.

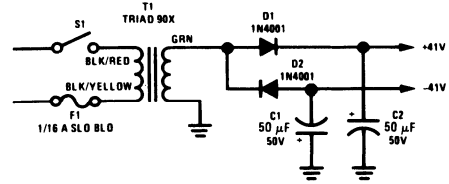
The negative regulator is simply a unity-gain inverter with input resistor, R6, and feedback resistor, R7.

The amplifiers must be compensated for unity-gain operation.

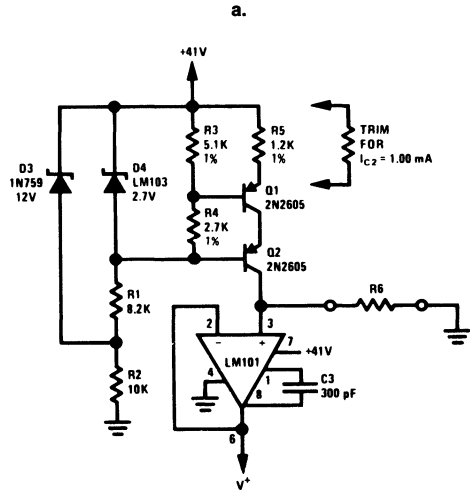
The power supply may be modulated by injecting current into the wiper of R4. In this case, the output voltage variations will be equal and opposite at the positive and negative outputs. The power supply voltage may be controlled by replacing D1, D2, R1 and R2 with a variable voltage reference.

PROGRAMMABLE BENCH POWER SUPPLY

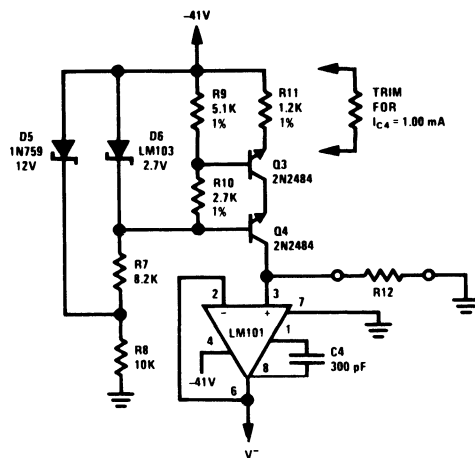
The complete power supply shown in Figure 28 is a programmable positive and negative power supply. The regulator section of the supply comprises two voltage followers whose input is provided by the voltage drop across a reference resistor of a precision current source.



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TL/H/6822-31



TL/H/6822-32

FIGURE 28. Low-Power Supply for Integrated Circuit Testing

Programming sensitivity of the positive and negative supply is $1V/1000\Omega$ of resistors R6 and R12 respectively. The output voltage of the positive regulator may be varied from approximately +2V to +38V with respect to ground and the negative regulator output voltage may be varied from -38V to 0V with respect to ground. Since LM107 amplifiers are used, the supplies are inherently short circuit proof. This current limiting feature also serves to protect a test circuit if this supply is used in integrated circuit testing.

Internally compensated amplifiers may be used in this application if the expected capacitive loading is small. If large capacitive loads are expected, an externally compensated amplifier should be used and the amplifier should be over-compensated for additional stability. Power supply noise may be reduced by bypassing the amplifier inputs to ground with capacitors in the 0.1 to 1.0 μF range.

CONCLUSIONS

The foregoing circuits are illustrative of the versatility of the integrated operational amplifier and provide a guide to a number of useful applications. The cautions noted in each section will show the more common pitfalls encountered in amplifier usage.

APPENDIX I

DEFINITION OF TERMS

Input Offset Voltage: That voltage which must be applied between the input terminals through two equal resistances to obtain zero output voltage.

Input Offset Current: The difference in the currents into the two input terminals when the output is at zero.

Input Bias Current: The average of the two input currents.

Input Voltage Range: The range of voltages on the input terminals for which the amplifier operates within specifications.

Common Mode Rejection Ratio: The ratio of the input voltage range to the peak-to-peak change in input offset voltage over this range.

Input Resistance: The ratio of the change in input voltage to the change in input current on either input with the other grounded.

Supply Current: The current required from the power supply to operate the amplifier with no load and the output at zero.

Output Voltage Swing: The peak output voltage swing, referred to zero, that can be obtained without clipping.

Large-Signal Voltage Gain: The ratio of the output voltage swing to the change in input voltage required to drive the output from zero to this voltage.

Power Supply Rejection: The ratio of the change in input offset voltage to change in power supply voltage producing it.

Slew Rate: The internally-limited rate of change in output voltage with a large-amplitude step function applied to the input.

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Designs for Negative Voltage Regulators

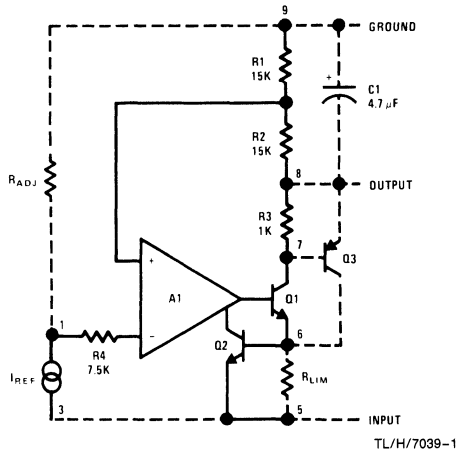
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Mexico

Introduction

A number of IC voltage regulators have been introduced to date, but these have been designed primarily to regulate positive voltages. Most can be adapted as negative regulators, at some sacrifice in complexity, performance and flexibility. This note, however, describes an IC, which is designed specifically as a negative regulator. It is intended to complement the LM100 and LM105 positive regulators, providing a line of IC's for practically every regulator application.

Unique features of the circuit are that it supplies any output voltage from 0V down to -40V, while operating from a single unregulated supply. The output voltage is proportional to a single programming resistor, and remote sensing can be done at the load. It also regulates within 0.01% in circuits using a separate, floating bias supply, where the maximum output voltage is limited only by the breakdown of external pass transistors. The device is designed for either linear or switching regulator applications.

In the circuits described, emphasis is placed on practical considerations for the design of reliable regulators. Many of the pitfalls which cause unexpected failures are explained, and protection schemes for many of the hazards facing regulators are given. Most of the design hints are sufficiently general to apply equally to other IC's or even regulators designed entirely with discrete components.



A functional diagram of the LM104 regulator and external circuitry (dash line) is shown in the figure. The internal reference is a temperature compensated current source, I_{REF} . A voltage which is proportional to an external programming resistor, R_{adj} , is fed into an error amplifier, A1. This drives an internal series pass transistor, Q1, to supply an output voltage equal to twice the voltage across the programming resistor. External pass transistors can be added, as is Q3, to

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Application Note 21



increase the output-current capability. Short-circuit protection makes the circuit exhibit a constant-current characteristic when Q2 is turned on by the voltage drop across an external current-limit resistor, R_{lim} . A more complete description of the integrated circuit itself is given in the back of the text.

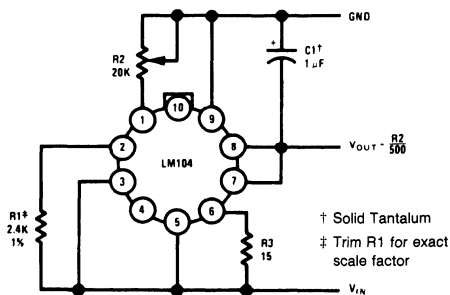
low power regulator or bias supply

This circuit can provide output voltages between 0V and -40V at currents up to 25 mA. The output voltage is linearly dependent on the value of R2, giving approximately 2V for each 1 K Ω of resistance. The exact scale factor can be set up by trimming R1. This should be done at the maximum output voltage setting in order to compensate for any mismatch in the internal divider resistors of the integrated circuit.

Short-circuit protection is provided by R3. The value of this resistor should be chosen so that the voltage drop across it is 300 mV at the maximum load current. This insures worst-case operation up to full load over a -55°C to 125°C temperature range. With a lower maximum operating temperature, the design value for this voltage can be increased linearly to 525 mV at 25°C.

For an output voltage setting of 15V, the regulation, no load to full load, is better than 0.05%; and the line regulation is better than 0.2% for a $\pm 20\%$ input voltage variation. Noise and ripple can be greatly reduced by bypassing R2 with a 10 μ F capacitor. This will keep the ripple on the output less than 0.5 mV for a 1V, 120 Hz ripple on the unregulated input. The capacitor also improves the line-transient response by a factor of five.

An output capacitor of at least 1 μ F is required to keep the regulator from oscillating. This should be a low inductance capacitor, preferably solid tantalum, installed with short leads. It is not usually necessary to bypass the input, but at least a 0.01 μ F bypass is advisable when there are long leads connecting the circuit to the unregulated power source.



† Solid Tantalum

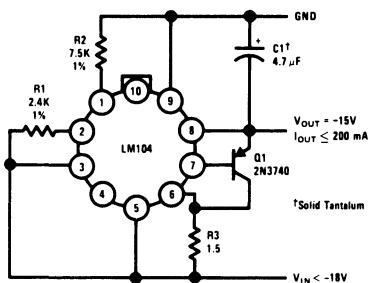
‡ Trim R1 for exact scale factor

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It is important to watch power dissipation in the integrated circuit even with load currents of 25 mA or less. The dissipation can be in excess of 1W with large input-output voltage differentials, and this is above ratings for the device.

Increased output current

When output currents above 25 mA are required or when the dissipation in the series pass transistor can be higher than about 0.2W, under worst-case conditions, it is advisable to add an external transistor to the LM104 to handle the power. The connection of an external booster transistor is shown here. The output current capability of the regulator is increased by the current gain of the added PNP transistor, but it is still necessary to watch dissipation in the external pass transistor. Excessive dissipation can burn out both the series pass transistor and the integrated circuit.



TL/H/7039-3

For example, with the circuit shown, the worst-case input voltage can be 25V. With a shorted output at 125°C, the current through the pass transistor will be 300 mA; and the dissipation in it will be 7.5W. This clearly establishes the need for an efficient heat sink.

For lower-power operation, a 2N2905 with a clip on heat sink can be used for the external pass transistor. However, when the worst case dissipation is above 0.5W, it is advisable to employ a power device such as the 2N3740 with a good heat sink.

The current limit resistor is chosen so that the voltage drop across it is 300 mV, with maximum load current, for operation to 125°C. With lower maximum ambients this voltage drop could be increased by 2.2 mV/°C. If possible, a fast-acting fuse rated about 25% higher than the maximum load current should be included in series with the unregulated input.

When a booster transistor is used, the minimum input-output voltage differential of the regulator will be increased by the emitter-base voltage of the added transistor. This establishes the minimum differential at 2 to 3V, depending on the base drive required by the external transistor.

high current regulator

When output currents in the ampere range are needed, it is necessary to add a second booster transistor to the LM104 circuitry. This connection is shown in the accompanying figure. The output current capability of the LM104 is increased by the product of the current gains of $Q1$ and $Q2$. However, it is still necessary to watch the dissipation in both the series pass transistor, $Q2$, and its driver, $Q1$. A clip-on heat sink is definitely required for $Q1$, and it is advisable to replace the 2N2905 with a 2N3740 which has a good heat sink when

output currents greater than 1A are needed. A 1000 pF capacitor should also be added between Pins 4 and 5 to compensate for the poorer frequency response of the 2N3740. The need for an efficient heat sink on $Q2$ should be obvious.

Experience shows that a single-diffused transistor such as a 2N3055 (or a 2N3772 for higher currents) is preferred over a double diffused, high-frequency transistor for the series pass element. The slower, single-diffused devices are less prone to secondary breakdown and oscillations in linear regulator applications.

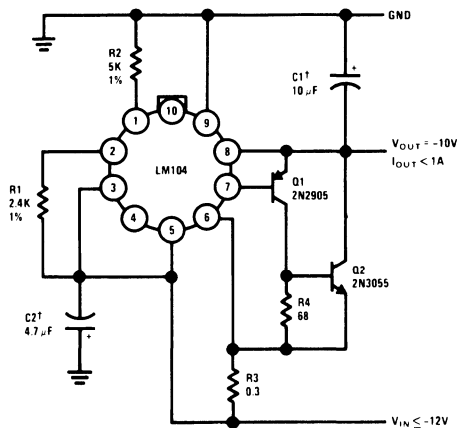
As with the lower-current regulators, $C1$ is required to frequency compensate the regulator and prevent oscillations. It is also advisable to bypass the input with $C2$ if the regulator is located any distance from the output filter of the unregulated supply. The resistor across the emitter base junction of $Q2$ fixes the minimum collector current of $Q1$ to minimize oscillation problems with light loads. It is still possible to experience oscillations with certain physical layouts, but these can almost always be eliminated by stringing a ferrite bead, such as a Ferroxcube K5-001-00/3B, on the emitter lead of $Q2$.

The use of two booster transistors does not appreciably increase the minimum input-output voltage differential over that for a single transistor. The minimum differential will be 2 to 3V, depending on the drive current required from the integrated circuit.

With high current regulators, remote sensing is sometimes required to eliminate the effect of line resistance between the regulator and the load. This can be accomplished by returning $R2$ and Pin 9 of the LM104 to the ground end of the load and connecting Pin 8 directly to the high end of the load.

The low resistance values required for the current limit resistor, $R3$, are sometimes not readily available. A suitable resistor can be made using a piece of resistance wire or even a short length of kovar lead wire from a standard TO-5 transistor.

The current limit sense voltage can be reduced to about 400 mV by inserting a germanium diode (or a diode-connected germanium transistor) in series with Pin 6 of the LM104. This diode will also compensate the sense voltage and make the short circuit current essentially independent of temperature.



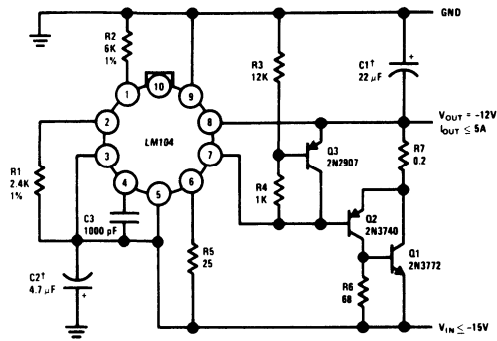
†Solid Tantalum

TL/H/7039-4

With high current regulators it is especially important to use a low-inductance capacitor on the output. The lead length on this capacitor must also be made short. Otherwise, the capacitor leads can resonate with smaller bypass capacitors (like 0.1 μF ceramic) which may be connected to the output. These resonances can lead to oscillations. With short leads on the output capacitor, the Q of the tuned circuit can be made low enough so that it cannot cause trouble.

foldback current limiting

High current regulators dissipate a considerable amount of power in the series pass transistor under full-load conditions. When the output is shorted, this dissipation can easily increase by a factor of four. Hence, with normal current limiting, the heat sink must be designed to handle much more power than the worst case full load dissipation if the circuit is to survive short-circuit conditions. This can increase the bulk of the regulator substantially.



†Solid Tantalum

TL/H/7039-5

This situation can be eased considerably by using foldback current limiting. With this method of current limiting, the available output current actually decreases as the maximum load on the regulator is exceeded and the output voltage falls off. The short-circuit current can be adjusted to be a fraction of the full load current, minimizing dissipation in the pass transistor.

The circuit shown here accomplishes just this. Normally Q3 is held in a non-conducting state by the voltage developed across R4. However, when the voltage across the current limit resistor, R7, increases to where it equals the voltage across R4 (about 1V), Q3 turns on and begins to rob base drive from the driver transistor, Q1. This causes an increase in the output current of the LM104, and it will go into current limiting at a current determined by R5. Since the base drive to Q1 is clamped, the output voltage will drop with heavier loads. This reduces the voltage drop across R4 and, therefore, the available output current. With the output completely shorted, the current will be about one-fifth the full-load current.

In design, R7 is chosen so that the voltage drop across it will be 1 to 2V under full load conditions. The resistance of R3 should be one-thousand times the output voltage. R4 is then determined from the following equation, where I_{FL} is the load current at which limiting will occur.

$$R_4 \cong \frac{R_7 R_3 I_{FL}}{V_{OUT} + 0.5}$$

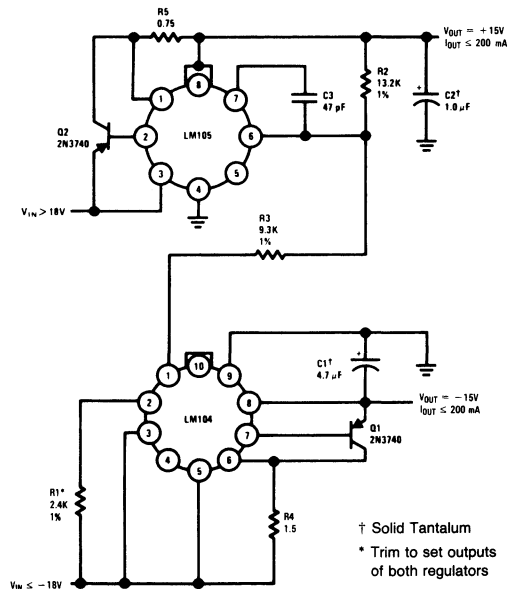
If it is desired to reduce the ratio of full load to short circuit current, this can be done by connecting a resistance of 2 to 10 k Ω across the emitter-base of Q3.

symmetrical power supplies

In many applications, such as powering operational amplifiers, there is a need for symmetrical positive and negative supply voltages. A circuit which is a particularly-economical solution to this design problem is shown in the adjoining figure. It uses a minimum number of components, and the voltage at both outputs can be set up within $\pm 1.5\%$ by a single adjustment. Further, the output voltages will tend to track with temperature and variations on the unregulated supply.

The positive voltage is regulated by an LM105, while an LM104 regulates the negative supply. The unusual feature is that the two regulators are interconnected by R3. This not only eliminates one precision resistor, but the reference current of the LM104 stabilizes the LM105 so that a $\pm 10\%$ variation in its reference voltage is only seen as a $\pm 3\%$ change in output voltage. This means that in many cases the output voltage of both regulators can be set up with sufficient accuracy by trimming a single resistor, R1.

The line regulation and temperature drift of the circuit is determined primarily by the LM104, so both output voltages will tend to track. Output ripple can be reduced by about a factor of five to less than 2 mV/V by bypassing Pin 1 of the



† Solid Tantalum

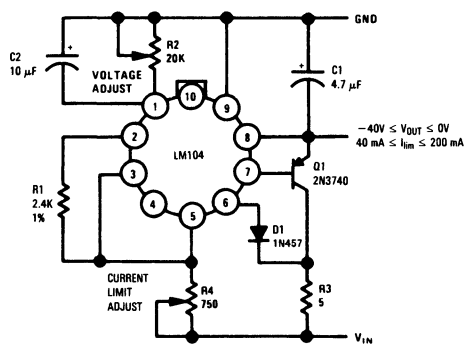
* Trim to set outputs of both regulators

TL/H/7039-6

LM104 to ground with a 10 μF capacitor. A center-tapped transformer with a bridge rectifier can be used for the unregulated power source.

adjustable current limiting

In laboratory power supplies, it is often necessary to adjust the limiting current of a regulator. This, of course, can be done by using a variable resistance for the current limit resistor. However, the current-limit resistor can easily have a value below that of commercially-available potentiometers. Discrete resistance values can be switched to vary the limiting current, but this does not provide continuously-variable adjustment.



TL/H/7039-7

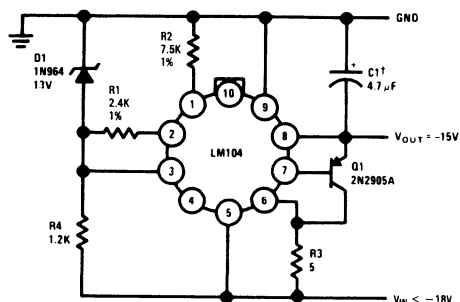
The circuit shown here solves this problem, giving a linear adjustment of limiting current over a five-to-one range. A silicon diode, D1, is included to reduce the current limit sense voltage to approximately 50 mV. Approximately 1.3 mA from the reference supply is passed through a potentiometer, R4, to buck out the diode voltage. Therefore, the effective current limit sense voltage is nearly proportional to the resistance of R4. The current through R4 is fairly insensitive to changes in ambient temperature, and D1 compensates for temperature variations in the current limit sense voltage of the LM104. Therefore, the limiting current will not be greatly affected by temperature.

It is important that a potentiometer be used for R4 and connected as shown. If a rheostat connection were used, it could open while it was being adjusted and momentarily increase the current limit sense voltage to many times its normal value. This could destroy the series pass transistors under short-circuit conditions.

The inclusion of R4 will soften the current limiting characteristics of the LM104 somewhat because it acts as an emitter-degeneration resistor for the current-limit transistor. This can be avoided by reducing the value of R4 and developing the voltage across R4 with additional bleed current to ground.

improving line regulation

The line regulation for voltage variations on the reference supply terminal of the LM104 is about five times worse than it is for changes on the unregulated input. Therefore, a zener-diode preregulator can be used on the reference supply to improve line regulation. This is shown in the figure below.



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TL/H/7039-8

The design of this circuit is fairly simple. It is only necessary that the minimum current through R4 be greater than 2 mA with low input voltage. Further, the zener voltage of D1 must be five volts greater than one-half the maximum output voltage to keep the transistors in the reference current source from saturating.

using protective diodes

It is a little known fact that most voltage regulators can be damaged by shorting out the unregulated input voltage while the circuit is operating—even though the output may have short-circuit protection. When the input voltage to the regulator falls instantaneously to zero, the output capacitor is still charged to the nominal output voltage. This applies voltage of the wrong polarity across the series pass transistor and other parts of the regulator, and they try to discharge the output capacitor into the short. The resulting current surge can damage or destroy these parts.

When the LM104 is used as the control element of the regulator, the discharge path is through internal junctions forward biased by the voltage reversal. If the charge on the output capacitor is in the order of 40 volt • μF, the circuit can be damaged during the discharge interval. However, the problem is not only seen with integrated circuit regulators. It also happens with discrete regulators where the series-pass transistor usually gets blown out.

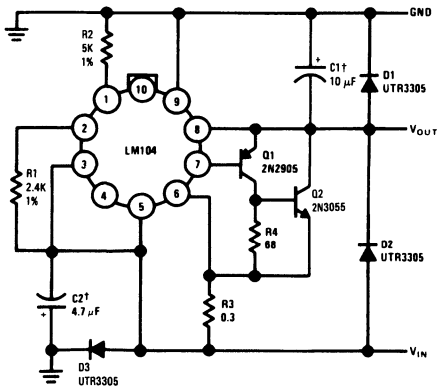
The problem can be eliminated by connecting a diode between the output and the input such that it discharges the output capacitor when the input is shorted. The diode should be capable of handling large current surges without excessive voltage drop, but it does not have to be a power diode since it does not carry current continuously. It should also be relatively fast. Ordinary rectifier diodes will not do because they look like an open circuit in the forward direction until minority carriers are injected into the intrinsic base region of the PIN structure.

This problem is not just caused by accidental physical shorts on the input. It has shown up more than once when regulators are driven from high-frequency dc-dc converters. Tantalum capacitors are frequently used as output filters for the rectifiers. When these capacitors are operated near their maximum voltage ratings with excessive high frequency ripple across them, they have a tendency to sputter—that is, short momentarily and clear themselves. When they short, they can blow out the regulator; but they look innocent after the smoke has cleared.

The solution to this problem is to use capacitors with conservative voltage ratings, to observe the maximum ripple ratings for the capacitor and to include a protective diode between the input and output of the regulator to protect it in case sputtering does occur.

Heavy loads operating from the unregulated supply can also destroy a voltage regulator. When the input power is switched off, the input voltage can drop faster than the output voltage, causing a voltage reversal across the regulator, especially when the output of the regulator is lightly loaded. Inductive loads such as a solenoid are particularly troublesome in this respect. In addition to causing a voltage reversal between the input and the output, they can reverse the input voltage causing additional damage.

In cases like this, it is advisable to use a multiple-pole switch or relay to disconnect the regulator from the unregulated supply separate from the other loads. If this cannot be done, it is necessary to put a diode across the input of the regulator to clamp any reverse voltages, in addition to the protective diode between the input and the output.



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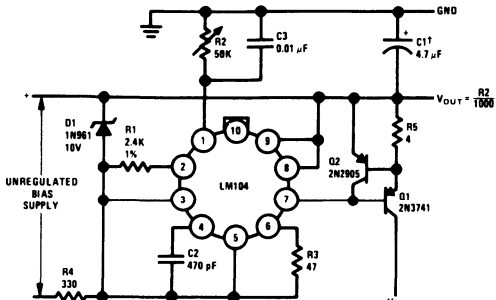
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Yet another failure mode can occur if the regulated supply drives inductive loads. When power is shut off, the inductive current can reverse the output voltage polarity, damaging the regulator and the output capacitor. This can be cured with a clamp diode on the output. Even without inductive loads it is usually good practice to include this clamp diode to protect the regulator if its output is accidentally shorted to a negative supply.

A regulator with all these protective diodes is shown here. D1 protects against output voltage reversal. D2 prevents a voltage reversal between the input and the output of the regulator. And D3 prevents a reversal of the input-voltage polarity. In many cases, D3 is not needed if D1 and D2 are used, since these diodes will clamp the input voltage within two diode drops of ground. This is adequate if the input voltage reversals are of short duration.

high voltage regulator

In the design of commercial power supplies, it is common practice to use a floating bias supply to power the control circuitry of the regulator. As shown here, this connection can be used with the LM104 to regulate output voltages that are higher than the ratings of the integrated circuit. Better regulation can also be obtained because it is a simple matter to preregulate the low current bias supply so that the integrated circuit does not see ripple or line voltage variations and because the reduced operating voltage minimizes power dissipation and associated thermal effects from the current delivered to the booster transistor.



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TL/H/7039-10

The bias for the LM104, which is normally obtained from a separate winding on the main power transformer, is pre-regulated by D1. R4 is selected so that it can provide the 3 mA operating current for the integrated circuit as well as the base drive of the booster transistor, Q1, with full load and minimum line voltage. The booster transistor regulates the voltage from the main supply, and its breakdown voltage will determine the maximum operating voltage of the complete regulator.

The connection of the LM104 is somewhat different than usual: the internal divider for the error amplifier is shorted out by connecting Pins 8 and 9 together. This makes the output voltage equal to the voltage drop across the adjustment resistor, R2, instead of twice this voltage as is normally the case. C2 and C3 must also be added to prevent oscillation. The value of C3 can be increased to 4.7 μ F to reduce noise on the output.

It is necessary to add Q2 and R5 to provide current limiting. When the output current becomes high enough to turn on Q2, there will be an abrupt rise in the output current of the LM104 as Q2 tries to remove base drive from the booster transistor. Any further increases in load current will cause the LM104 to limit at a current determined by R3, and the output voltage will collapse. The value of R3 must be selected so that the integrated circuit can deliver the base current of Q1, at full load, without limiting.

A second, NPN booster transistor can be used in a compound connection with Q1 to increase the output current of the regulator. However, with very-high-voltage regulators, the most economical solution may be to use a high voltage PNP driving a vacuum tube for the series pass element.

Remote sensing, which eliminates the effects of voltage dropped in the leads connecting the regulator to the load, can be provided by connecting R2 to the ground end of the load and Pins 8 and 9 to the high end of the load.

switching regulator

Linear regulators have the advantages of fast response to load transients as well as low noise and ripple. However, since they must dissipate the difference between the unregulated-supply power and the output power, they sometimes have a low efficiency. This is not always a problem with ac line-operated equipment because the power loss is easily afforded, because the input voltage is already fairly well regulated and because losses can be minimized by adjustment of transformer ratios in the power supply. In systems operating from a fixed dc input voltage, the situation is often much different. It might be necessary to regulate a 28V input voltage down to 5V. In this case, the power loss can quickly become excessive. This is true even if efficiency is not one of the more important criteria, since high power dissipation calls for expensive power transistors and elaborate heat sinking methods.

Switching regulators can be used to greatly reduce dissipation. Efficiencies approaching 90% can be realized even though the regulated output voltage is only a fraction of the input voltage. With proper design, transient response and ripple can also be made quite acceptable.

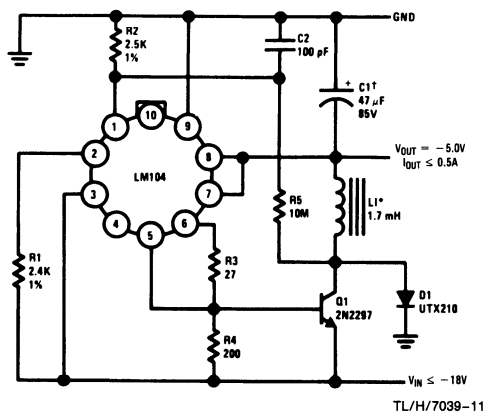
This circuit, which uses the LM104 as a self-oscillating switching regulator, operates in much the same way as a linear regulator. The reference current is set up at 1 mA with R1, and R2 determines the output voltage in the normal fashion. The circuit is made to oscillate by applying positive feedback through R5 to the non-inverting input on the error amplifier of the LM104. When the output voltage is low, the

internal pass transistor of the integrated circuit turns on and drives Q1 into saturation. The current feedback through R5 then increases the magnitude of the reference voltage developed across R2. Q1 will remain on until the output voltage comes up to twice this reference voltage. At this point, the error amplifier goes into linear operation, and the positive feedback makes the circuit switch off. When this happens, the reference voltage is lowered by feedback through R5, and the circuit will stay off until the output voltage drops to where the error amplifier again goes into linear operation. Hence, the circuit regulates with the output voltage oscillating about the nominal value with a peak-to-peak ripple of around 40 mV.

The power conversion from the input voltage to a lower output voltage is obtained by the action of the switch transistor, Q1, the catch diode, D1, and the LC filter. The inductor is made large enough so that the current through it is essentially constant throughout the switching cycle. When Q1 turns on, the voltage on its collector will be nearly equal to the unregulated input voltage. When it turns off, the magnetic field in L1 begins to collapse, driving the collector voltage of Q1 to ground where it is clamped by D1.

If, for example, the input voltage is 10V and the switch transistor is driven at a 50% duty cycle, the average voltage on the collector of Q1 will be 5V. This waveform will be filtered by L1 and C1 and appear as a 5V dc voltage on the output. Since the inductor current comes from the input while Q1 is on but from ground through D1 while Q1 is off, the average value of the input current will be half the output current. The power output will therefore equal the input power if switching losses are neglected.

In design, the value of R3 is chosen to provide sufficient base drive to Q1 at the maximum load current. R4 must be low enough so that the bias current coming out of Pin 5 of the LM104 (approximately 300 μ A) does not turn on the switch transistor. The purpose of C2 is to remove transients that can appear across R2 and cause erratic switching. It should not be made so large that it severely integrates the waveform fed back to this point.

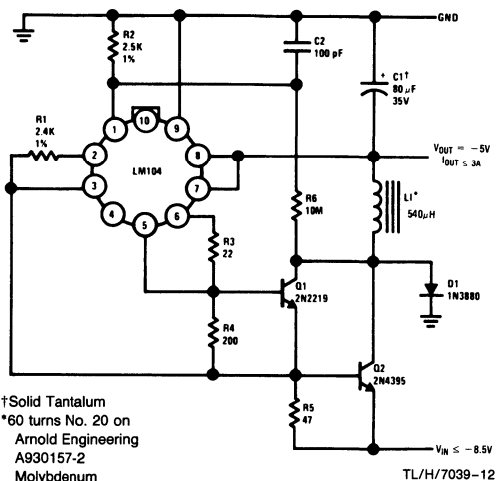


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A262123-2
Molybdenum Permalloy Core

high current switching regulator

Output currents up to 3A can be obtained using the switching regulator circuit shown here. The circuit is identical to the one described previously, except that Q2 has been added to increase the output current capability by about an order of magnitude. It should be noted that the reference supply terminal is returned to the base of Q2, rather than the unregulated input. This is done because the LM104 will not function properly if Pin 5 gets more than 2V more positive than Pin 3. The reference current, as well as the bias currents for Pins 3 and 5, is supplied from the unregulated input through R5, so its resistance must be low enough so that Q2 is not turned on with about 2 mA flowing through it.

The line regulation of this circuit is worsened somewhat by the unregulated input voltage being fed back into the reference for the regulator through R6. This effect can be eliminated by connecting a 0.01 μ F capacitor in series with R6 to remove the dc component of the feedback.



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There are a number of precautions that should be observed with all switching regulators, although they are more inclined to cause problems in high-current applications:

For one, fast switching diodes and transistors must be used. If D1 is an ordinary junction rectifier, voltages in the order of 10V can be developed across it in the forward direction when the switch transistor turns off. This happens because low-frequency rectifiers are usually manufactured with a PIN structure which presents a high forward impedance until enough minority carriers are injected into the diode base region to increase its conductance. This not only causes excessive dissipation in the diode, but the diode also presents a short circuit to the switch transistor, when it first turns on, until all the charge stored in the base region of the diode is removed. Similarly, a high frequency switch transistor must be used as excessive switching losses in low frequency transistors, like the 2N3055, make them overheat.

It is important that the core material used for the inductor have a soft saturation characteristic. Cores that saturate abruptly produce excessive peak currents in the switch transistor if the output current becomes high enough to run the core close to saturation. Powdered molybdenum-permalloy cores, on the other hand, exhibit a gradual reduction in per-

meability with excessive current, so the only effect of output currents above the design value is a gradual increase in switching frequency.

One thing that is frequently overlooked in the design of switching circuits is the ripple rating of the filter capacitors. Excessive high-frequency ripple can cause these capacitors to fail. This is an especially-important consideration for capacitors used on the unregulated input as the ripple current through them can be higher than the dc load current. The situation is eased somewhat for the filter capacitor on the output of the regulator since the ripple current is only a fraction of the load current. Nonetheless, proper design usually requires that the voltage rating of this capacitor be higher than that dictated by the DC voltage across it for reliable operation.

One unusual problem that has been noted in working with switching regulators is excessive dissipation in the switch transistors caused by high emitter-base saturation voltage. This can also show up as erratic operation if Q1 is the defective device. This saturation voltage can be as high as 5V and is the result of poor alloying on the base contact of the transistor. A defective transistor will not usually show up on a curve tracer because the low base current needed for linear operation does not produce a large voltage drop across the poorly-alloyed contact. However, a bad device can be spotted by probing on the bases of the switch transistors while the circuit is operating.

It is necessary that the catch diode, D1, and any bypass capacitance on the unregulated input be returned to ground separately from the other parts of the circuit. These components carry large current transients and can develop appreciable voltage transients across even a short length of wire. If C1, C2, or R2 have any common ground impedance with the catch diode or the input bypass capacitor, the transients can appear directly on the output.

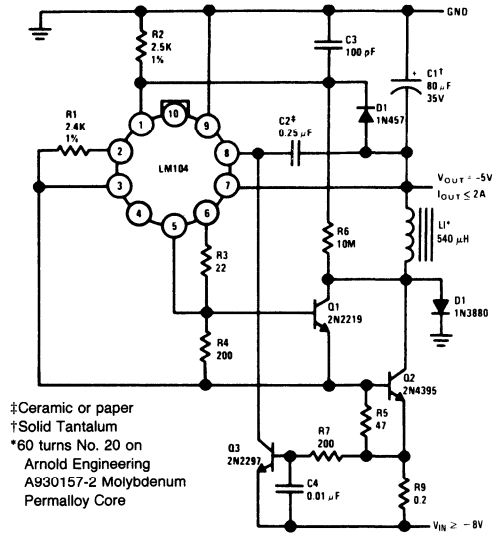
switching regulator with current limiting

The switching regulator circuits described previously are not protected from overloads or a short-circuited output. The current limiting of the LM104 is used to limit the base drive of the switch transistor, but this does not effectively protect the switch transistor from excessive current. Providing short circuit protection is no simple problem, since it is necessary to keep the regulator operating in the switching mode when the output is shorted. Otherwise, the dissipation in the switch transistor will become excessive even though the current is limited.

A circuit which provides current limiting and protects the regulator from short circuits is shown here. The current through the switch transistor produces a voltage drop across R9. When this voltage becomes large enough to turn on Q3, current limiting is initiated. This occurs because Q3 takes over as the control transistor and regulates the voltage on Pin 8 of the LM104. This point, which is the feedback terminal of the error amplifier, is separated from the actual output of the regulator by not shorting the regulated output and booster output terminals of the integrated circuit. Hence, with excessive output current, the circuit still operates as a switching regulator with Q3 regulating the voltage fed back to the error amplifier as the output voltage falls off.

A resistor, R7, is included so that excessive base current will not be driven into the base of Q3. C4 insures that Q3 does not turn on from the current spikes through the switch transistor caused by pulling the stored charge out of the catch diode (these are about twice the load current). This

capacitor also operates in conjunction with C2 to produce sufficient phase delay in the feedback loop so that the circuit will oscillate in current limiting. However, C4 should not be made so large that it appreciably integrates the rectangular waveform of the current through the switch transistor.



As the output voltage falls below half the design value, D1 pulls down the reference voltage across R2. This permits the current limiting circuitry to keep operating when the unregulated input voltage drops below the design value of output voltage, with a short on the output of the regulator.

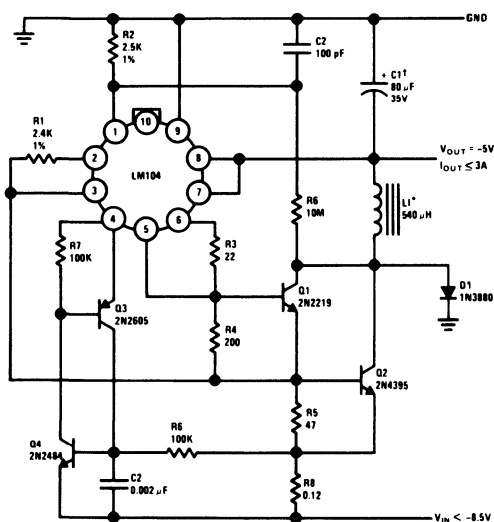
A transistor with good high-current capability was chosen for Q3 so that it does not suffer from secondary breakdown effects from the large peak currents (about 200 mA) through it. With a shorted output, these peak currents occur with the full input voltage across Q3. The average dissipation in Q3 is, however, low.

switching regulator with overload shutoff

An alternate method for protecting a switching regulator from excessive output currents is shown here. When the output current becomes too high, the voltage drop across the current-sense resistor, R8, fires an SCR which shuts off the regulator. The regulator remains off, dissipating practically no power, until it is reset by removing the input voltage. In the actual circuit, complementary transistors, Q3 and Q4, replace the SCR since it is difficult to find devices with a low enough holding current (about 25 μA). When the voltage drop across R8 becomes large enough to turn on Q4, this removes the base drive for the output transistors of the LM104 through Pin 4. When this happens Q3 latches Q4, holding the regulator off until the input voltage is removed. It will then start when power is applied if the overload has been removed.

With this circuit, it is necessary that the shutoff current be 1.5 times the full load current. Otherwise, the circuit will shut off when it is switched on with a full load because of the excess current required to charge the output capacitor. The shutoff current can be made closer to the full load current by connecting a 10 μF capacitor across R2 which will limit the charging current for C1 by slowing the risetime of the

output voltage when the circuit is turned on. However, this capacitor will also bypass the positive feedback from R6 which makes the regulator oscillate. Therefore, it is necessary to put a 270Ω resistor in the ground end of the added capacitor and provide feedback to this resistor from the collector of Q1 through a 1 MΩ resistor.

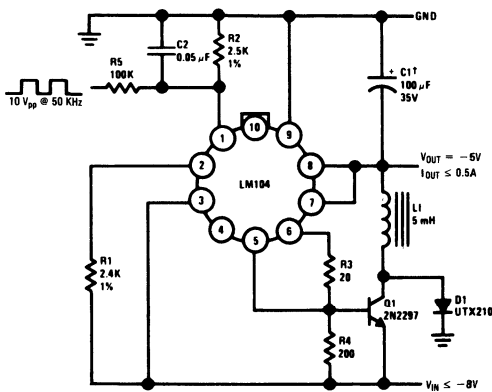


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driven switching regulator

When a number of switching regulators are operated from a common power source, it is desirable to synchronize their operation to more uniformly distribute the switched current waveforms in the input line. Synchronous operation can also be beneficial when a switching regulator is operated in conjunction with a power converter.



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A circuit which synchronizes the switching regulator with a square wave drive signal is shown here. It differs from the switching regulators described previously in that positive feedback is not used. Instead, a triangular wave with a peak-to-peak amplitude of 25 mV is applied to the noninverting input of the error amplifier. The waveform is obtained by integrating the square wave synchronizing signal. This triangular wave causes the error amplifier to switch because its gain is high enough that the waveform easily overdrives it. The switching duty cycle is controlled by the output voltage fed back to the error amplifier. If the output voltage goes up, the duty cycle will decrease since the error amplifier will pick off a smaller portion of the triangular wave. Similarly, the duty cycle will decrease if the output voltage drops. Hence, the duty cycle is controlled to produce the desired output voltage.

Without a synchronous drive signal, the circuit will self oscillate at a frequency determined by L1 and C1. This self-oscillation frequency must be lower than the synchronous drive frequency. Therefore, more filtering is required for a driven regulator than for a self-oscillating regulator operating at the same frequency. This also means that a driven regulator will have less output ripple.

The value of C2 is chosen so that its capacitive reactance at the drive frequency is less than one-tenth the resistance of R2. The amplitude of the triangular wave is set at 25 mV with R5. It is advisable to ac couple the drive signal by putting a capacitor in series with R5 so that it does not disturb the dc reference voltage developed for the error amplifier.

the LM104 regulator

The basic reference for the regulator is zener diode D1. The reference diode is supplied from a PNP current source, Q8, which has a fixed current gain of 2. This arrangement permits the circuit to operate with unregulated input voltages as low as 7V, substantially increasing the efficiency of low-voltage regulators.

The reference supply is temperature compensated by using the negative temperature coefficient of the transistor emitter-base voltages to cancel the positive coefficient of the zener diode. The design produces a nominal 2.4V between the reference and reference supply terminals of the integrated circuit. Connecting an external 2.4 KΩ resistor between those terminals gives a 1 mA reference current from the collectors of Q1 and Q2, which is independent of temperature. The reference voltage supplied to the error amplifier is developed across a second external resistor connected between the adjustment terminal and ground.

The reference supply terminal is normally connected to the unregulated supply. However, improved line regulation can be obtained by preregulating the voltage on this terminal. This improvement occurs because Q1, Q2, and Q7 do not see changes in input voltage. Normally, it is the change in the emitter-base voltage of these transistors with changes in collector-base voltage which determines the line regulation.

When the reference supply and unregulated input terminals are operated from separate voltage sources, it is important to make sure that the unregulated input terminal of the integrated circuit does not get more than 2V more positive than the reference supply terminal. If this happens, the collector-isolation junction of Q6 becomes forward biased and disrupts the reference.

The error amplifier of the regulator is quite similar to the LM101 operational amplifier. Emitter follower input transistors, Q18 and Q19, drive a dual PNP which is operated in the common-base configuration. The current gain of these PNP transistors is fixed at 4 so that the base can be driven by a current source (Q13). Active collector loads are used for the input stage so that a voltage gain of 2000 is obtained. Q21 and Q22 provide enough current gain to keep the internal, series-pass transistor from loading the input stage. R14 limits the base drive on Q23 when it saturates with low, unregulated input voltages. The collector of Q23 is brought out separately so that an external booster transistor can be added for increased output current capability. R13 established the minimum operating current in Q23 when booster transistors are used.

One feature of the error amplifier is that it operates properly with common mode voltages all the way up to ground. Because of this, the circuit will regulate with output voltages to zero volts.

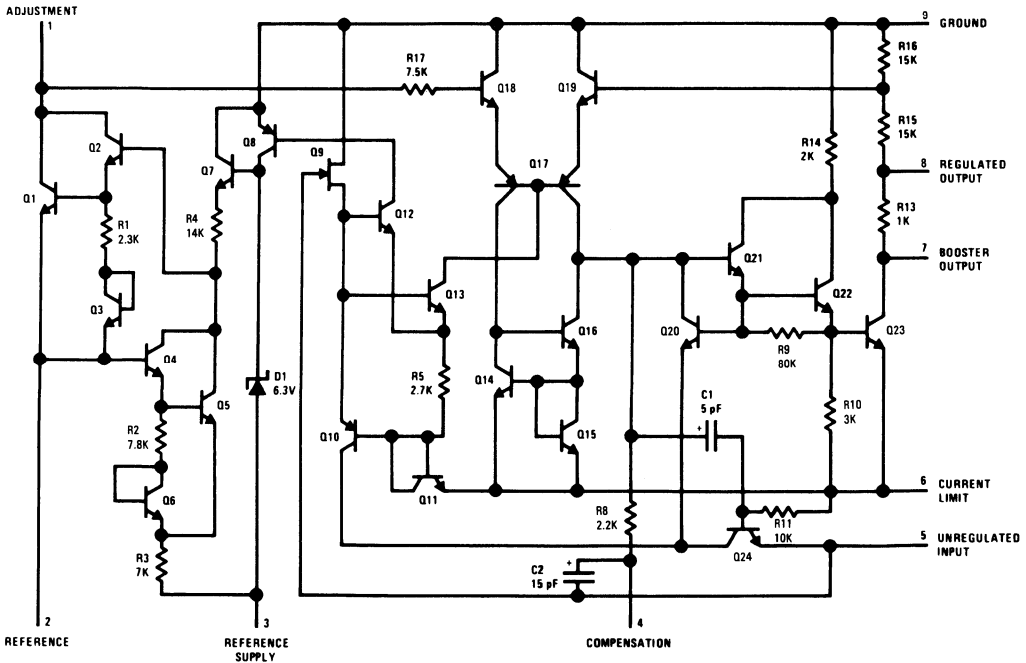
Current limiting is provided by Q24. When the voltage between the current limit and unregulated input terminals becomes large enough to turn on Q24, it will pull Q10 out of saturation and remove base drive from Q21 through Q20.

This causes the series pass transistor to exhibit a constant current characteristic. The pre-load current, provided for Q24 by Q10 before current limiting is initiated, gives a much sharper current-limit characteristic. C1 and R11 are included in the limiting circuitry to suppress oscillations.

The error amplifier is connected to a divider on the output (R15 and R16) to keep the reference current generator from saturating with low input-output voltage differentials. A compensating resistor, R17, which is equal to the equivalent resistance of the divider is included to minimize offset error in the error amplifier.

The major feedback loop is frequency compensated by the brute-force method of rolling off the response with a relatively large capacitor on the output. C2 is included on the integrated circuit to compensate for the effects of series resistance in the output capacitor. A compensation point is also brought out so that more capacitance can be added across C2 for certain regulator configurations. R8 improves the load-transient response, especially when compensation is added on Pin 4.

The purpose of Q9, which is a collector FET, is to bias the current-source transistors, Q12 and Q13. It also supplies the pre-load current for the current-limit transistor, Q24, through Q10.



TL/H/7039-16

The LM105-An Improved Positive Regulator

National Semiconductor
Application Note 23



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Introduction

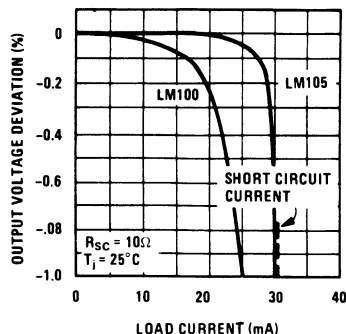
IC voltage regulators are seeing rapidly increasing usage. The LM100, one of the first, has already been widely accepted. Designed for versatility, this circuit can be used as a linear regulator, a switching regulator, a shunt regulator, or even a current regulator. The output voltage can be set between 2V and 30V with a pair of external resistors, and it works with unregulated input voltages down to 7V. Dissipation limitations of the IC package restrict the output current to less than 20 mA, but external transistors can be added to obtain output currents in excess of 5A. The LM100 and an extensive description of its use in many practical circuits are described in References 1-3.

One complaint about the LM100 has been that it does not have good enough regulation for certain applications. In addition, it becomes difficult to prove that the load regulation is satisfactory under worst-case design conditions. These problems prompted development of the LM105, which is nearly identical to the LM100 except that a gain stage has been added for improved regulation. In the great majority of applications, the LM105 is a plug-in replacement for the LM100.

the improved regulator

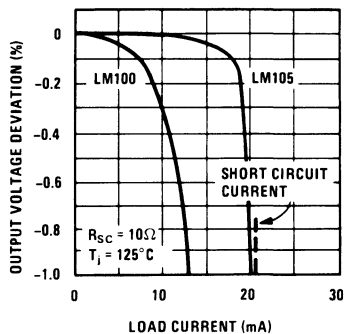
The load regulation of the LM100 is about 0.1%, no load to full load, without current limiting. When short circuit protection is added, the regulation begins to degrade as the output current becomes greater than about half the limiting current. This is illustrated in *Figure 1*. The LM105, on the other hand, gives 0.1% regulation up to currents closely approaching the short circuit current. As shown in *Figure 1b*, this is particularly significant at high temperatures.

The current limiting characteristics of a regulator are important for two reasons: First, it is almost mandatory that a regulator be short-circuit protected because the output is distributed to enough places that the probability of it becoming shorted is quite high. Secondly, the sharpness of the limiting characteristics is not improved by the addition of external booster transistors. External transistors can increase the maximum output current, but they do not improve the load regulation at currents approaching the short



TL/H/6906-1

a. $T_j = 25^\circ\text{C}$



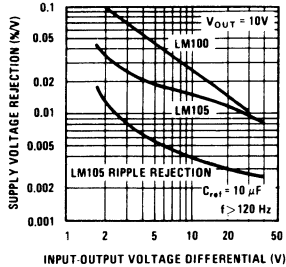
TL/H/6906-2

b. $T_j = 125^\circ\text{C}$

Figure 1. Comparison between the load regulation of the LM100 and LM105 for equal short circuit currents

circuit current. Thus, it can be seen that the LM105 provides more than ten times better load regulation in practical power supply designs.

Figure 2 shows that the LM105 also provides better line regulation than the LM100. These curves give the percentage change in output voltage for an incremental change in the unregulated input voltage. They show that the line regulation is worst for small differences between the input and output voltages. The LM105 provides about three times better regulation under worst case conditions. Bypassing the internal reference of the regulator makes the ripple rejection of the LM105 almost a factor of ten better than the LM100 over the entire operating range, as shown in the figure. This bypass capacitor also eliminates noise generated in the internal reference zener of the IC.



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Figure 2. Comparison between the line regulation characteristics of the LM100 and LM105

The LM105 has also benefited from the use of new IC components developed after the LM100 was designed. These have reduced the internal power consumption so that the LM105 can be specified for input voltages up to 50V and output voltages to 40V. The minimum preload current required by the LM100 is not needed on the LM105.

circuit description

The differences between the LM100 and the LM105 can be seen by comparing the schematic diagrams in Figures 3 and 4. Q4 and Q5 have been added to the LM105 to form a common-collector, common-base, common-emitter amplifier, rather than the single common-emitter differential amplifier of the LM100.

In the LM100, generation of the reference voltage starts with zener diode, D1, which is supplied with a fixed current from one of the collectors of Q2. This regulated voltage, which has a positive temperature coefficient, is buffered by

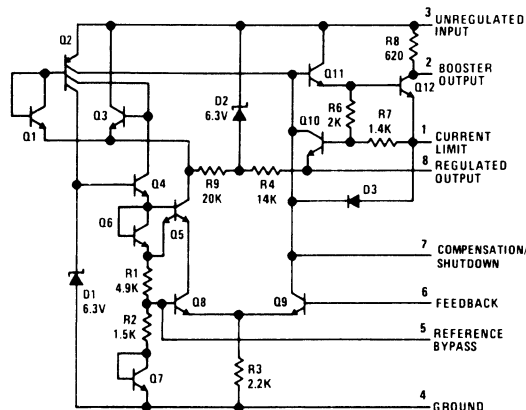
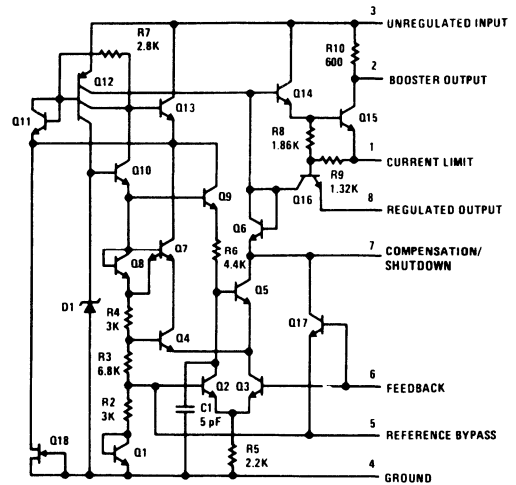


Figure 3. Schematic diagram of the LM100 regulator

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TL/H/6906-5

Figure 4. Schematic diagram of the LM105 regulator

Q4, divided down by R1 and R2 and connected in series with a diode-connected transistor, Q7. The negative temperature coefficient of Q7 cancels out the positive coefficient of the voltage across R2, producing a temperature-compensated 1.8V on the base of Q8. This point is also brought outside the circuit so that an external capacitor can be added to bypass any noise from the zener diode.

Transistors Q8 and Q9 make up the error amplifier of the circuit. A gain of 2000 is obtained from this single stage by using a current source, another collector on Q2, as a collector load. The output of the amplifier is buffered by Q11 and used to drive the series-pass transistor, Q12. The collector of Q12 is brought out so that an external PNP transistor, or PNP-NPN combination, can be added for increased output current.

Current limiting is provided by Q10. When the voltage across an external resistor connected between Pins 1 and 8 becomes high enough to turn on Q10, it removes the base drive from Q11 so the regulator exhibits a constant-current characteristic. Prebiasing the current limit transistor with a portion of the emitter-base voltage of Q12 from R6 and R7 reduces the current limit sense voltage. This increases the

efficiency of the regulator, especially when foldback current limiting is used. With foldback limiting, the voltage dropped across the current sense resistor is about four times larger than the sense voltage.

As for the remaining details, the collector of the amplifier, Q9, is brought out so that external collector-base capacitance can be added to frequency-stabilize the circuit when it is used as a linear regulator. This terminal can also be grounded to shut the regulator off. R9 and R4 are used to start up the regulator, while the rest of the circuitry establishes the proper operating levels for the current source transistor, Q2.

The reference circuitry of the LM105 is the same, except that the current through the reference divider, R2, R3 and R4, has been reduced by a factor of two on the LM105 for reduced power consumption. In the LM105, Q2 and Q3 form an emitter coupled amplifier, with Q3 being the emitter-follower input and Q2 the common-base output amplifier. R6 is the collector load for this stage, which has a voltage gain of about 20. The second stage is a differential amplifier, using Q4 and Q5. Q5 actually provides the gain. Since it has a current source as a collector load, one of the collectors of Q12, the gain is quite high: about 1500. This gives a total gain in the error amplifier of about 30,000 which is ten times higher than the LM100.

It is not obvious from the schematic, but the first stage (Q2 and Q3) and second stage (Q4 and Q5) of the error amplifier are closely balanced when the circuit is operating. This will be true regardless of the absolute value of components and over the operating temperature range. The only thing affecting balance is component matching, which is good in a monolithic integrated circuit, so the error amplifier has good drift characteristics over a wide temperature range.

Frequency compensation is accomplished with an external integrating capacitor around the error amplifier, as with the LM100. This scheme makes the stability insensitive to loading conditions—resistive or reactive—while giving good transient response. However, an internal capacitor, C1, is added to prevent minor-loop oscillations due to the increased gain.

Additional differences between the LM100 and LM105 are that a field-effect transistor, Q18, connected as a current source starts the regulator when power is first applied. Since this current source is connected to ground, rather than the output, the minimum load current before the regulator drops out of operation with large input-output voltage differentials is greatly reduced. This also minimizes power dissipation in the integrated circuit when the difference between the input and output voltage is at the worst-case value. With the LM105 circuit configuration, it was also necessary to add Q17 to eliminate a latch-up mechanism which could exist with lower output-voltage settings. Without Q17, this could occur when Q3 saturated and cut off the second stage amplifiers, Q4 and Q5, causing the output to latch at a voltage nearly equal to the unregulated input.

power limitations

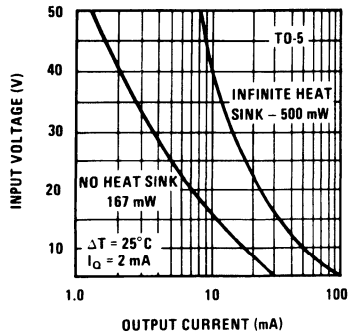
Although it is desirable to put as much of the regulator as possible on the IC chip, there are certain basic limitations. For one, it is not a good idea to put the series pass transistor on the chip. The power that must be dissipated in the pass transistor is too much for practical IC packages. Further, IC's must be rated at a lower maximum operating temperature than power transistors. This means that even with a power package, a more massive heat sink would be required if the pass transistor was included in the IC.

Assuming that these problems could be solved, it is still not advisable to put the pass transistor on the same chip with the reference and control circuitry: changes in the unregulated input voltage or load current produce gross variations in chip temperature. These variations worsen load and line regulation due to temperature interaction with the control and reference circuitry.

To elaborate, it is reasonable to neglect the package problem since it is potentially solvable. The lower, maximum operating temperatures of IC's, however, present a more basic problem. The control circuitry in an IC regulator runs at fairly low currents. As a result, it is more sensitive to leakage currents and other phenomena which degrades the performance of semiconductors at high temperatures. Hence, the maximum operating temperature is limited to 150°C in military temperature range applications. On the other hand, a power transistor operating at high currents may be run at temperatures up to 200°C, because even a 1 mA leakage current would not affect its operation in a properly designed circuit. Even if the pass transistor developed a permanent 1 mA leakage from channeling, operating under these conditions of high stress, it would not affect circuit operation. These conditions would not trouble the pass transistor, but they would most certainly cause complete failure of the control circuitry.

These problems are not eliminated in applications with a lower maximum operating temperature. Integrated circuits are sold for limited temperature range applications at considerably lower cost. This is mainly based on a lower maximum junction temperature. They may be rated so that they do not blow up at higher temperatures, but they are not guaranteed to operate within specifications at these temperatures. Therefore, in applications with a lower maximum ambient temperature, it is necessary to purchase an expensive full temperature range part in order to take advantage of the theoretical maximum operating temperatures of the IC.

Figure 5 makes the point about dissipation limitations more strongly. It gives the maximum short circuit output current for an IC regulator in a TO-5 package, assuming a 25°C temperature rise between the chip and ambient and a quiescent current of 2 mA. Dual-in-line or flat packages give results which are, at best, slightly better, but are usually worse. If the short circuit current is not of prime concern, *Figure 5* can also be used to give the maximum output current as a function of input-output voltage differential. However, the increased dissipation due to the quiescent current flowing at the maximum input voltage must be taken into account. In addition, the input-output differential must be measured with the maximum expected input voltages.



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Figure 5. Dissipation limited short circuit output current for an IC regulator in a TO-5 package

The 25°C temperature rise assumed in arriving at *Figure 5* is not at all unreasonable. With military temperature range parts, this is valid for a maximum junction temperature of 150°C with a 125°C ambient. For low cost parts, marketed for limited temperature range applications, this maximum differential appropriately derates the maximum junction temperature.

In practical designs, the maximum permissible dissipation will always be to the left of the curve shown for an infinite heat sink in *Figure 5*. This curve is realized with the package immersed in circulating acetone, freon or mineral oil. Most heat sinks are not quite as good.

To summarize, power transistors can be run with a temperature differential, junction to ambient, 3 to 5 times as great as an integrated circuit. This means that they can dissipate much more power, even with a smaller heat sink. This, coupled with the fact that low cost, multilead power packages are not available and that there can be thermal interactions between the control circuitry and the pass transistor, strongly suggests that the pass transistors be kept separate from the integrated circuit.

using booster transistors

Figure 6 shows how an external pass transistor is added to the LM105. The addition of an external PNP transistor does not increase the minimum input output voltage differential.

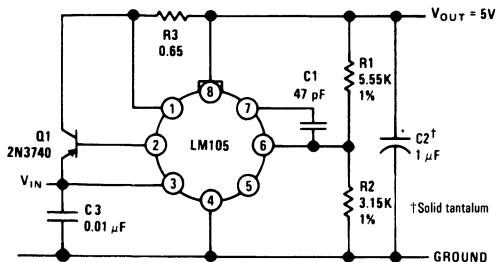


Figure 6. 0.2A regulator

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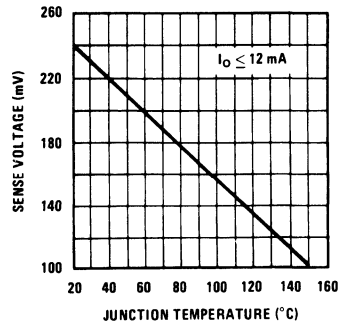
This would happen if an NPN transistor was used in a compound emitter follower connection with the NPN output transistor of the IC. A single-diffused, wide base transistor like the 2N3740 is recommended because it causes fewer oscillation problems than double-diffused, planar devices. In addition, it seems to be less prone to failure under overload conditions; and low cost devices are available in power packages like the TO-66 or even TO-3.

When the maximum dissipation in the pass transistor is less than about 0.5W, a 2N2905 may be used as a pass transistor. However, it is generally necessary to carefully observe thermal deratings and provide some sort of heat sink.

In the circuit of *Figure 6*, the output voltage is determined by R1 and R2. The resistor values are selected based on a feedback voltage of 1.8V to Pin 6 of the LM105. To keep thermal drift of the output voltage within specifications, the parallel combination of R1 and R2 should be approximately 2K. However, this resistance is not critical. Variations of $\pm 30\%$ will not cause an appreciable degradation of temperature drift.

The 1 μ F output capacitor, C2, is required to suppress oscillations in the feedback loop involving the external booster transistor, Q1, and the output transistor of the LM105. C1 compensates the internal regulator circuitry to make the stability independent for all loading conditions. C3 is not normally required if the lead length between the regulator and the output filter of the rectifier is short.

Current limiting is provided by R3. The current limit resistor should be selected so that the maximum voltage drop across it, at full load current, is equal to the voltage given in *Figure 7* at the maximum junction temperature of the IC. This assures a no load to full load regulation better than 0.1% under worst-case conditions.

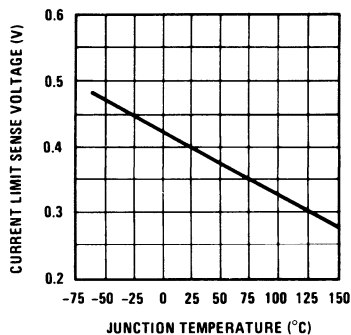


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Figure 7. Maximum voltage drop across current limit resistor at full load for worst case load regulation of 0.1%

The short circuit output current is also determined by R3. *Figure 8* shows the voltage drop across this resistor, when the output is shorted, as a function of junction temperature in the IC.

With the type of current limiting used in *Figure 6*, the dissipation under short circuit conditions can be more than three times the worst-case full load dissipation. Hence, the heat



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Figure 8. Voltage drop across current limit resistor required to initiate current limiting

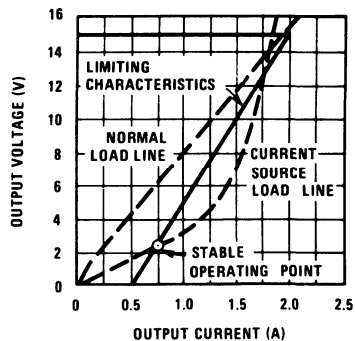
sink for the pass transistor must be designed to accommodate the increased dissipation if the regulator is to survive more than momentarily with a shorted output. It is encouraging to note, however, that the short circuit current will decrease at higher ambient temperatures. This assists in protecting the pass transistor from excessive heating.

foldback current limiting

With high current regulators, the heat sink for the pass transistor must be made quite large in order to handle the power dissipated under worst-case conditions. Making it more than three times larger to withstand short circuits is sometimes inconvenient in the extreme. This problem can be solved with foldback current limiting, which makes the output current under overload conditions decrease below the full load current as the output voltage is pulled down. The short circuit current can be made but a fraction of the full load current.

A high current regulator using foldback limiting is shown in *Figure 9*. A second booster transistor, Q1, has been added to provide 2A output current without causing excessive dissipation in the LM105. The resistor across its emitter base junction bleeds off any collector base leakage and establishes a minimum collector current for Q2 to make the circuit easier to stabilize with light loads. The foldback characteristic is produced with R4 and R5. The voltage across R4 bucks out the voltage dropped across the current sense resistor, R3. Therefore, more voltage must be developed across R3 before current limiting is initiated. After the output voltage begins to fall, the bucking voltage is reduced, as it is proportional to the output voltage. With the output shorted,

the current is reduced to a value determined by the current limit resistor and the current limit sense voltage of the LM105.



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Figure 10. Limiting characteristics of regulator using foldback current limiting

Figure 10 illustrates the limiting characteristics. The circuit regulates for load currents up to 2A. Heavier loads will cause the output voltage to drop, reducing the available current. With a short on the output, the current is only 0.5A.

In design, the value of R3 is determined from

$$R_3 = \frac{V_{lim}}{I_{SC}}, \quad (1)$$

where V_{lim} is the current limit sense voltage of the LM105, given in *Figure 8*, and I_{SC} is the design value of short circuit current. R5 is then obtained from

$$R_5 = \frac{V_{OUT} + V_{sense}}{I_{bleed} + I_{bias}}, \quad (2)$$

where V_{OUT} is the regulated output voltage, V_{sense} is maximum voltage across the current limit resistor for 0.1% regulation as indicated in *Figure 7*, I_{bleed} is the preload current on the regulator output provided by R5 and I_{bias} is the maximum current coming out of Pin 1 of the LM105 under full load conditions. I_{bias} will be equal to 2 mA plus the worst-case base drive for the PNP booster transistor, Q2. I_{bleed} should be made about ten times greater than I_{bias} .

Finally, R4 is given by

$$R_4 = \frac{I_{FL} R_3 - V_{sense}}{I_{bleed}}, \quad (3)$$

where I_{FL} is the output current of the regulator at full load.

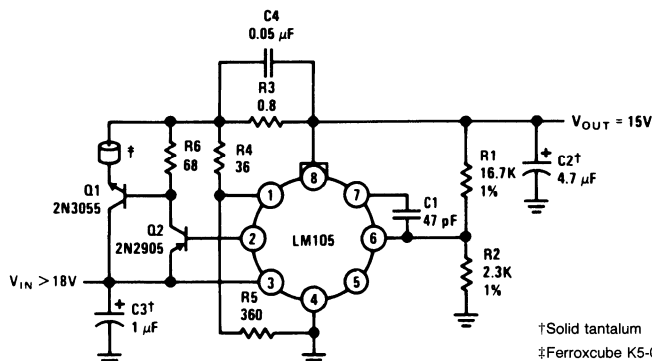


Figure 9. 2A regulator with foldback current limiting

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It is recommended that a ferrite bead be strung on the emitter of the pass transistor, as shown in *Figure 9*, to suppress oscillations that may show up with certain physical configurations. It is advisable to also include C4 across the current limit resistor.

In some applications, the power dissipated in Q2 becomes too great for a 2N2905 under worst-case conditions. This can be true even if a heat sink is used, as it should be in almost all applications. When dissipation is a problem, the 2N2905 can be replaced with a 2N3740. With a 2N3740, the ferrite bead and C4 are not needed because this transistor has a lower cutoff frequency.

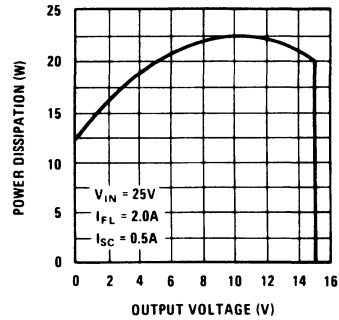
One of the advantages of foldback limiting is that it sharpens the limiting characteristics of the IC. In addition, the maximum output current is less sensitive to variations in the current limit sense voltage of the IC: in this circuit, a 20% change in sense voltage will only affect the trip current by 5%. The temperature sensitivity of the full load current is likewise reduced by a factor of four, while the short circuit current is not.

Even though the voltage dropped across the sense resistor is larger with foldback limiting, the minimum input-output voltage differential of the complete regulator is not increased above the 3V specified for the LM105 as long as this drop is less than 2V. This can be attributed to the low sense voltage of the IC by itself.

Figure 10 shows that foldback limiting can only be used with certain kinds of loads. When the load looks predominately like a current source, the load line can intersect the foldback characteristic at a point where it will prevent the regulator from coming up to voltage, even without an overload. Fortunately, most solid state circuitry presents a load line which does not intersect. However, the possibility cannot be ignored, and the regulator must be designed with some knowledge of the load.

With foldback limiting, power dissipation in the pass transistor reaches a maximum at some point between full load and

short circuited output. This is illustrated in *Figure 11*. However, if the maximum dissipation is calculated with the worst-case input voltage, as it should be, the power peak is not too high.

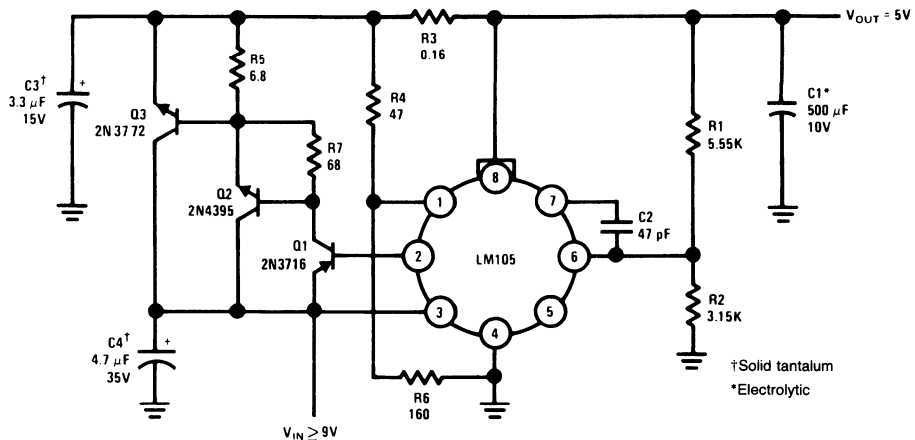


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Figure 11. Power dissipation in series pass transistors under overload conditions in regulator using foldback current limiting

high current regulator

The output current of a regulator using the LM105 as a control element can be increased to any desired level by adding more booster transistors, increasing the effective current gain of the pass transistors. A circuit for a 10A regulator is shown in *Figure 12*. A third NPN transistor has been included to get higher current. A low frequency device is used for Q3 because it seems to better withstand abuse. However, high frequency transistors must be used to drive it. Q2 and Q3 are both double-diffused transistors with good frequency response. This insures that Q3 will present the dominant lag in the feedback loop through the booster transistors, and back around the output transistor of the LM105. This is further insured by the addition of C3.



†Solid tantalum
*Electrolytic

Figure 12. 10A regulator with foldback current limiting

TL/H/6906-13

The circuit, as shown, has a full load capability of 10A. Fold-back limiting is used to give a short circuit output current of 2.5A. The addition of Q3 increases the minimum input-output voltage differential, by 1V, to 4V.

dominant failure mechanisms

By far, the biggest reason for regulator failures is overdissipation in the series pass transistors. This has been borne out by experience with the LM100. Excessive heating in the pass transistors causes them to short out, destroying the IC. This has happened most frequently when PNP booster transistors in a TO-5 can, like the 2N2905, were used. Even with a good heat sink, these transistors cannot dissipate much more than 1W. The maximum dissipation is less in many applications. When a single PNP booster is used and power can be a problem, it is best to go to a transistor like the 2N3740, in a TO-66 power package, using a good heat sink.

Using a compound PNP/NPN booster does not solve all problems. Even when breadboarding with transistors in TO-3 power packages, heat sinks must be used. The TO-3 package is not very good, thermally, without a heat sink. Dissipation in the PNP transistor driving the NPN series pass transistor cannot be ignored either. Dissipation in the driver with worst-case current gain in the pass transistor must be taken into account. In certain cases, this could require that a PNP transistor in a power package be used to drive the NPN pass transistor. In almost all cases, a heat sink is required if a PNP driver transistor in a TO-5 package is selected.

With output currents above 3A, it is good practice to replace a 2N3055 pass transistor with a 2N3772. The 2N3055 is rated for higher currents than 3A, but its current gain falls off rapidly. This is especially true at either high temperatures or low input-output voltage differentials. A 2N3772 will give substantially better performance at high currents, and it makes life much easier for the PNP driver.

The second biggest cause of failures has been the output filter capacitors on power inverters providing unregulated power to the regulator. If these capacitors are operated with excessive ripple across them, and simultaneously near their maximum dc voltage rating, they will sputter. That is, they short momentarily and clear themselves. When they short, the output capacitor of the regulator is discharged back

through the reverse biased pass transistors or the control circuitry, frequently causing destruction. This phenomenon is especially prevalent when solid tantalum capacitors are used with high-frequency power inverters. The maximum ripple allowed on these capacitors decreases linearly with frequency.

The solution to this problem is to use capacitors with conservative voltage ratings. In addition, the maximum ripple allowed by the manufacturer at the operating frequency should also be observed.

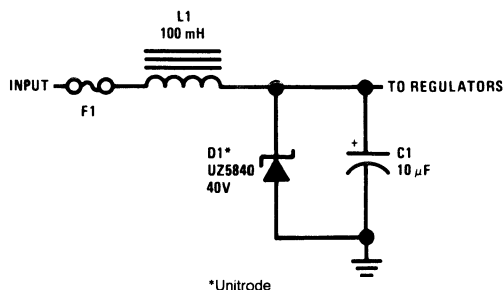
The problem can be eliminated completely by installing a diode between the input and output of the regulator such that the capacitor on the output is discharged through this diode if the input is shorted. A fast switching diode should be used as ordinary rectifier diodes are not always effective.

Another cause of problems with regulators is severe voltage transients on the unregulated input. Even if these transients do not cause immediate failure in the regulator, they can feed through and destroy the load. If the load shorts out, as is frequently the case, the regulator can be destroyed by subsequent transients.

This problem can be solved by specifying all parts of the regulator to withstand the transient conditions. However, when ultimate reliability is needed, this is not a good solution. Especially since the regulator can withstand the transient, yet severely overstress the circuitry on its output by feeding the transients through. Hence, a more logical recourse is to include circuitry which suppresses the transients. A method of doing this is shown in *Figure 13*. A zener diode, which can handle large peak currents, clamps the input voltage to the regulator while an inductor limits the current through the zener during the transient. The size of the inductor is determined from

$$L = \frac{\Delta V \Delta t}{I} \quad (4)$$

where ΔV is the voltage by which the input transient exceeds the breakdown voltage of the diode, Δt is the duration of the transient and I is the peak current the zener can handle while still clamping the input voltage to the regulator. As shown, the suppression circuit will clamp 70V, 4 ms transients on the unregulated supply.



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Figure 13. Suppression circuitry to remove large voltage spikes from unregulated supplies

conclusions

The LM105 is an exact replacement for the LM100 in the majority of applications, providing about ten times better regulation. There are, however, a few differences:

In switching regulator applications,² the size of the resistor used to provide positive feedback should be doubled as the impedance seen looking back into the reference bypass terminal is twice that of the LM100 (2 k Ω versus 1 k Ω). In addition, the minimum output voltage of the LM105 is 4.5V, compared with 2V for the LM100. In low voltage regulator applications, the effect of this is obvious. However, it also imposes some limitations on current regulator and shunt regulator designs.³ Lastly, clamping the compensation terminal (Pin 7) within a diode drop of ground or the output terminal will not guarantee that the regulator is shut off, as it will with the LM100. This restricts the LM105 in the overload shutdown schemes³ which can be used with the LM100.

Dissipation limitations of practical packages dictate that the output current of an IC regulator be less than 20 mA. However, external booster transistors can be added to get any output current desired. Even with satisfactory packages, considerably larger heat sinks would be needed if the pass transistors were put on the same chip as the reference and control circuitry, because an IC must be run at a lower maximum temperature than a power transistor. In addition, heat dissipated in the pass transistor couples into the low level circuitry and degrades performance. All this suggests that the pass transistor be kept separate from the IC.

Overstressing series pass transistors has been the biggest cause of failures with IC regulators. This not only applies to the transistors within the IC, but also to the external booster transistors. Hence, in designing a regulator, it is of utmost importance to determine the worst-case power dissipation in all the driver and pass transistors. Devices must then be selected which can handle the power. Further, adequate heat sinks must be provided as even power transistors cannot dissipate much power by themselves.

Normally, the highest power dissipation occurs when the output of the regulator is shorted. If this condition requires heat sinks which are so large as to be impractical, foldback current limiting can be used. With foldback limiting, the power dissipated under short circuit conditions can actually be made less than the dissipation at full load.

The LM105 is designed primarily as a positive voltage regulator. A negative regulator, the LM104, which is a functional complement to the LM105, is described in Reference 4.

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A Simplified Test Set for Op Amp Characterization

National Semiconductor
Application Note 24
M. Yamatake



AN-24

INTRODUCTION

The test set described in this paper allows complete quantitative characterization of all dc operational amplifier parameters quickly and with a minimum of additional equipment. The method used is accurate and is equally suitable for laboratory or production test—for quantitative readout or for limit testing. As embodied here, the test set is conditioned for testing the LM709 and LM101 amplifiers; however, simple changes discussed in the text will allow testing of any of the generally available operational amplifiers.

Amplifier parameters are tested over the full range of common mode and power supply voltages with either of two output loads. Test set sensitivity and stability are adequate for testing all presently available integrated amplifiers.

The paper will be divided into two sections, i.e., a functional description, and a discussion of circuit operation. Complete construction information will be given including a layout for the tester circuit boards.

FUNCTIONAL DESCRIPTION

The test set operates in one of three basic modes. These are: (1) Bias Current Test; (2) Offset Voltage, Offset Current Test; and (3) Transfer Function Test. In the first two of these tests, the amplifier under test is exercised throughout its full common mode range. In all three tests, power supply voltages for the circuit under test may be set at $\pm 5V$, $\pm 10V$, $\pm 15V$, or $\pm 20V$.

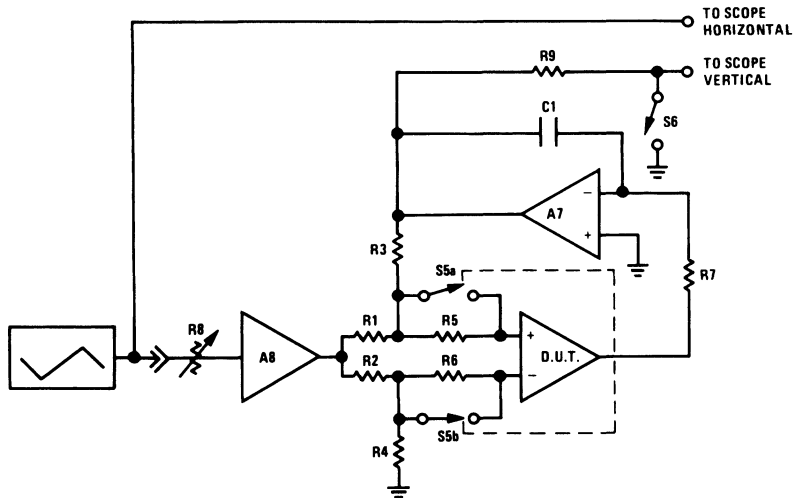
POWER SUPPLY

Basic waveforms and dc operating voltages for the test set are derived from a power supply section comprising a positive and a negative rectifier and filter, a test set voltage regulator, a test circuit voltage regulator, and a function generator. The dc supplies will be discussed in the section dealing with detailed circuit description.

The waveform generator provides three output functions, a $\pm 19V$ square wave, a $-19V$ to $+19V$ pulse with a 1% duty cycle, and a $\pm 5V$ triangular wave. The square wave is the basic waveform from which both the pulse and triangular wave outputs are derived.

The square wave generator is an operational amplifier connected as an astable multivibrator. This amplifier provides an output of approximately $\pm 19V$ at 16 Hz. This square wave is used to drive junction FET switches in the test set and to generate the pulse and triangular waveforms.

The pulse generator is a monostable multivibrator driven by the output of the square wave generator. This multivibrator is allowed to swing from negative saturation to positive saturation on the positive going edge of the square wave input and has a time constant which will provide a duty cycle of approximately 1%. The output is approximately $-19V$ to $+19V$.



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FIGURE 1. Functional Diagram of Bias Current Test Circuit

The triangular wave generator is a dc stabilized integrator driven by the output of the square wave generator and provides a $\pm 5V$ output at the square wave frequency, inverted with respect to the square wave.

The purpose of these various outputs from the power supply section will be discussed in the functional description.

BIAS CURRENT TEST

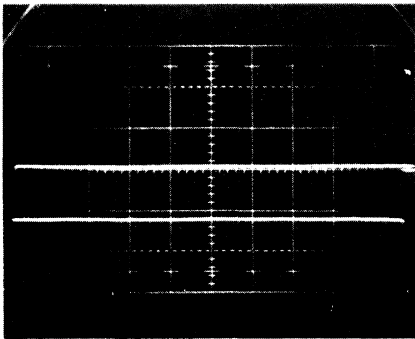
A functional diagram of the bias current test circuit is shown in *Figure 1*. The output of the triangular wave generator and the output of the test circuit, respectively, drive the horizontal and vertical deflection of an oscilloscope.

The device under test, (cascaded with the integrator, A_7), is connected in a differential amplifier configuration by R_1 , R_2 , R_3 , and R_4 . The inputs of this differential amplifier are driven in common from the output of the triangular wave generator through attenuator R_8 and amplifier A_8 . The inputs of the device under test are connected to the feedback network through resistors R_5 and R_6 , shunted by the switch S_{5a} and S_{5b} .

The feedback network provides a closed loop gain of 1,000 and the integrator time constant serves to reduce noise at the output of the test circuit as well as allowing the output of the device under test to remain near zero volts.

The bias current test is accomplished by allowing the device under test to draw input current to one of its inputs through the corresponding input resistor on positive going or negative going halves of the triangular wave generator output. This is accomplished by closing S_{5a} or S_{5b} on alternate halves of the triangular wave input. The voltage appearing across the input resistor is equal to input current times the input resistor. This voltage is multiplied by 1,000 by the feedback loop and appears at the integrator output and the vertical input of the oscilloscope. The vertical separation of the traces representing the two input currents of the amplifier under test is equivalent to the total bias current of the amplifier under test.

The bias current over the entire common mode range may be examined by setting the output of A_8 equal to the amplifier common mode range. A photograph of the bias current oscilloscope display is given as *Figure 2*. In this figure, the total input current of an amplifier is displayed over a $\pm 10V$ common mode range with a sensitivity of 100 nA per vertical division.



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FIGURE 2. Bias Current and Common Mode Rejection Display

The bias current display of *Figure 2* has the added advantage that incipient breakdown of the input stage of the device under test at the extremes of the common mode range is easily detected.

If either or both the upper or lower trace in the bias current display exhibits curvature near the horizontal ends of the oscilloscope face, then the bias current of that input of the amplifier is shown to be dependent on common mode voltage. The usual causes of this dependency are low breakdown voltage of the differential input stage or current sink.

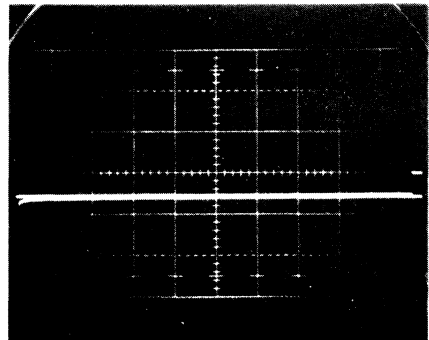
OFFSET VOLTAGE, OFFSET CURRENT TEST

The offset voltage and offset current tests are performed in the same general way as the bias current test. The only difference is that the switches S_{5a} and S_{5b} are closed on the same half-cycle of the triangular wave input.

The synchronous operation of S_{5a} and S_{5b} forces the amplifier under test to draw its input currents through matched high and low input resistors on alternate halves of the input triangular wave. The difference between the voltage drop across the two values of input resistors is proportional to the difference in input current to the two inputs of the amplifier under test and may be measured as the vertical spacing between the two traces appearing on the face of the oscilloscope.

Offset voltage is measured as the vertical spacing between the trace corresponding to one of the two values of source resistance and the zero volt baseline. Switch S_6 and Resistor R_9 are a base line chopper whose purpose is to provide a baseline reference which is independent of test set and oscilloscope drift. S_6 is driven from the pulse output of the function generator and has a duty cycle of approximately 1% of the triangular wave.

Figure 3 is a photograph of the various waveforms presented during this test. Offset voltage and offset current are displayed at a sensitivity of 1 mV and 100 nA per division, respectively, and both parameters are displayed over a common mode range of $\pm 10V$.



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FIGURE 3. Offset Voltage, Offset Current and Common Mode Rejection Display

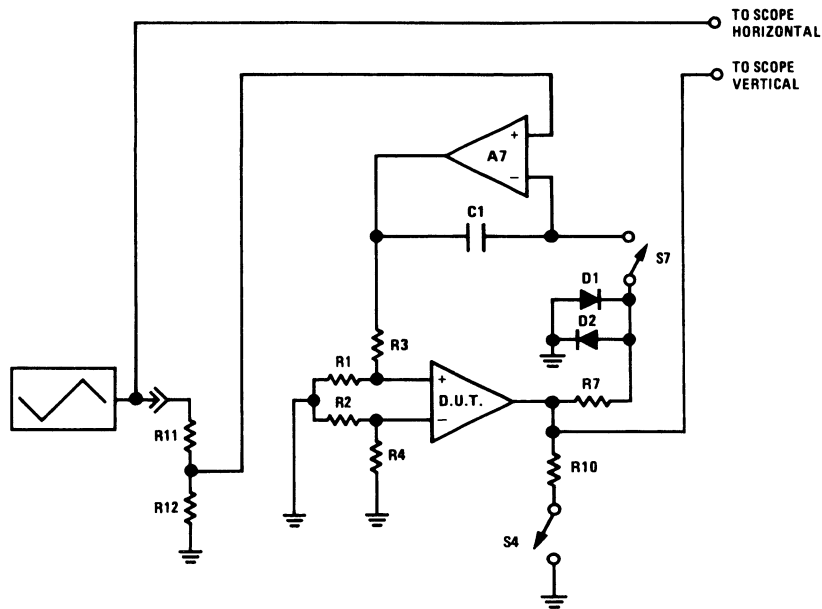


FIGURE 4. Functional Diagram of Transfer Function Circuit

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TRANSFER FUNCTION TEST

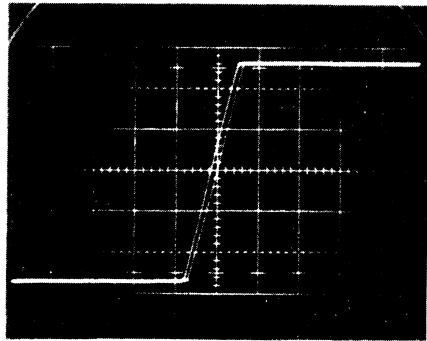
A functional diagram of the transfer function test is shown in *Figure 4*. The output of the triangular wave generator and the output of the circuit under test, respectively, drive the horizontal and vertical inputs of an oscilloscope.

The device under test is driven by a ± 2.5 mV triangular wave derived from the ± 5 V output of the triangular wave generator through the attenuators R_{11} , R_{12} , and R_1 , R_3 and through the voltage follower, A_7 . The output of the device under test is fed to the vertical input of an oscilloscope.

Amplifier A_7 performs a dual function in this test. When S_7 is closed during the bias current test, a voltage is developed across C_1 equal to the amplifier offset voltage multiplied by the gain of the feedback loop. When S_7 is opened in the transfer function test, the charge stored in C_1 continues to provide this offset correction voltage. In addition, A_7 sums the triangular wave test signal with the offset correction voltage and applies this sum to the input of the amplifier under test through the attenuator R_1 , R_3 . This input sweeps the input of the amplifier under test ± 2.5 mV around its offset voltage.

Figure 5 is a photograph of the output of the test set during the transfer function test. This figure illustrates the function of amplifier A_7 in adjusting the dc input of the test device so that its transfer function is displayed on the center of the oscilloscope face.

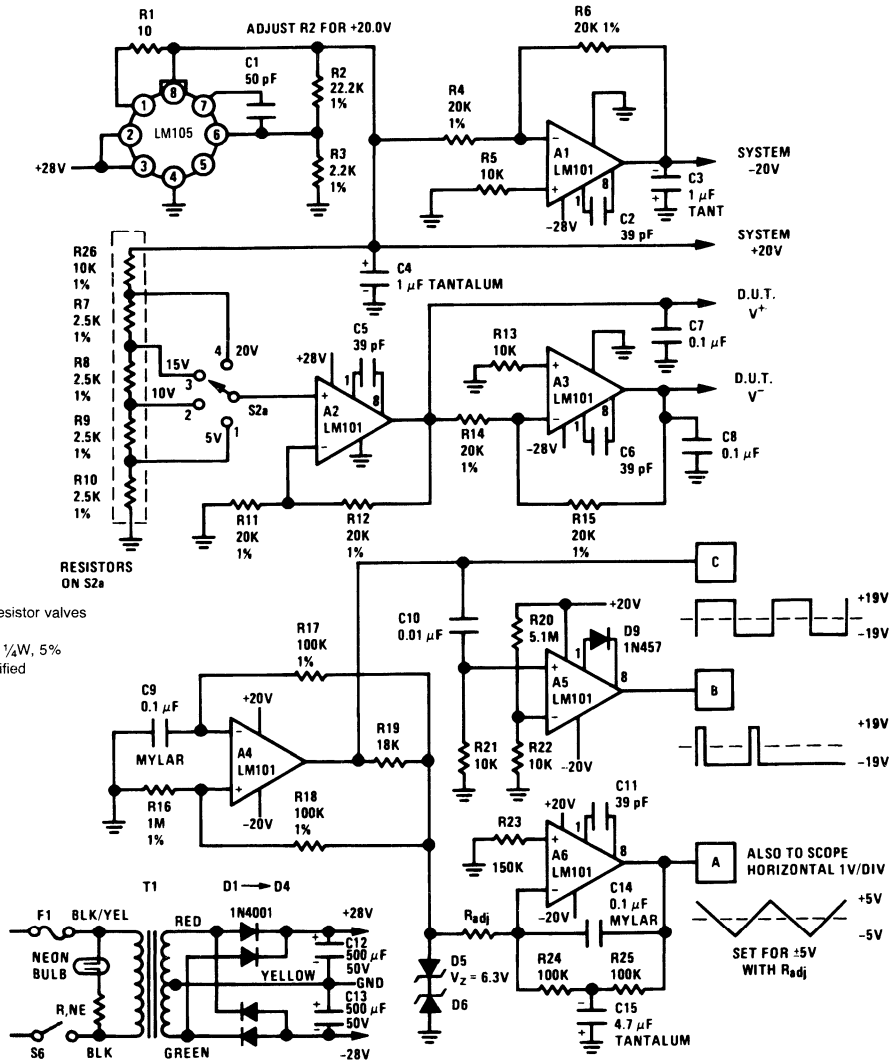
The transfer function display is a plot of V_{IN} vs V_{OUT} for an amplifier. This display provides information about three amplifier parameters: gain, gain linearity, and output swing.



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FIGURE 5. Transfer Function Display

Gain is displayed as the slope, $\Delta V_{OUT}/\Delta V_{IN}$ of the transfer function. Gain linearity is indicated change in slope of the V_{OUT}/V_{IN} display as a function of output voltage. This display is particularly useful in detecting crossover distortion in a Class B output stage. Output swing is measured as the vertical deflection of the transfer function at the horizontal extremes of the display.



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DETAILED CIRCUIT DESCRIPTION

POWER SUPPLIES

As shown in Figure 6, which is a complete schematic of the power supply and function generator, two power supplies are provided in the test set. One supply provides a fixed $\pm 20V$ to power the circuitry in the test set; the other provides $\pm 5V$ to $\pm 20V$ to power the circuit under test.

The test set power supply regulator accepts $+28V$ from the positive rectifier and filter and provides $+20V$ through the LM100 positive regulator. Amplifier A₁ is powered from the negative rectifier and filter and operates as a unity gain inverter whose input is $+20V$ from the positive regulator, and whose output is $-20V$.

The test circuit power supply is referenced to the $+20V$ output of the positive regulator through the variable divider

comprising R₇, R₈, R₉, R₁₀, and R₂₆. The output of this divider is $+10V$ to $+2.5V$ according to the position of S_{2a} and is fed to the non-inverting, gain-of-two amplifier, A₂. A₂ is powered from $+28V$ and provides $+20V$ to $+5V$ at its output. A₃ is a unity gain inverter whose input is the output of A₂ and which is powered from $-28V$. The complementary outputs of amplifiers A₂ and A₃ provide dc power to the circuit under test.

LM101 amplifiers are used as A₂ and A₃ to allow operation from one ground referenced voltage each and to provide protective current limiting for the device under test.

FUNCTION GENERATOR

The function generator provides three outputs, a $\pm 19V$ square wave, a $-19V$ to $+19V$ pulse having a 1% duty cycle, and a $\pm 5V$ triangular wave. The square wave is the

basic function from which the pulse and triangular wave are derived, the pulse is referenced to the leading edge of the square wave, and the triangular wave is the inverted and integrated square wave.

Amplifier A_4 is an astable multivibrator generating a square wave from positive to negative saturation. The amplitude of this square wave is approximately $\pm 19V$. The square wave frequency is determined by the ratio of R_{18} to R_{16} and by the time constant, $R_{17}C_9$. The operating frequency is stabilized against temperature and power regulation effects by regulating the feedback signal with the divider R_{19} , D_5 and D_6 .

Amplifier A_5 is a monostable multivibrator triggered by the positive going output of A_4 . The pulse width of A_5 is determined by the ratio of R_{20} to R_{22} and by the time constant $R_{21}C_{10}$. The output pulse of A_5 is an approximately 1% duty cycle pulse from approximately $-19V$ to $+19V$.

Amplifier A_6 is a dc stabilized integrator driven from the amplitude-regulated output of A_4 . Its output is a $\pm 5V$ triangular wave. The amplitude of the output of A_6 is determined by the square wave voltage developed across D_5 and D_6 and the time constant $R_{adj}C_{14}$. DC stabilization is accomplished by the feedback network R_{24} , R_{25} , and C_{15} . The ac attenuation of this feedback network is high enough so that the integrator action at the square wave frequency is not degraded.

Operating frequency of the function generator may be varied by adjusting the time constants associated with A_4 , A_5 , and A_6 in the same ratio.

TEST CIRCUIT

A complete schematic diagram of the test circuit is shown in *Figure 7*. The test circuit accepts the outputs of the power supplies and function generator and provides horizontal and vertical outputs for an X-Y oscilloscope, which is used as the measurement system.

The primary elements of the test circuit are the feedback buffer and integrator, comprising amplifier A_7 and its feedback network C_{16} , R_{31} , R_{32} , and C_{17} , and the differential amplifier network, comprising the device under test and the feedback network R_{40} , R_{43} , R_{44} , and R_{52} . The remainder of the test circuit provides the proper conditioning for the device under test and scaling for the oscilloscope, on which the test results are displayed.

The amplifier A_8 provides a variable amplitude source of common mode signal to exercise the amplifier under test over its common mode range. This amplifier is connected as a non-inverting gain-of-3.6 amplifier and receives its input from the triangular wave generator. Potentiometer R_{37} allows the output of this amplifier to be varied from ± 0 volts to ± 18 volts. The output of this amplifier drives the differential input resistors, R_{43} and R_{44} , for the device under test.

The resistors R_{46} and R_{47} are current sensing resistors which sense the input current of the device under test. These resistors are switched into the circuit in the proper sequence by the field effect transistors Q_6 and Q_7 . Q_6 and Q_7 are driven from the square wave output of the function generator by the PNP pair, Q_{10} and Q_{11} , and the NPN pair, Q_8 and Q_9 . Switch sections S_{1b} and S_{1c} select the switching sequence for Q_8 and Q_9 and hence for Q_6 and Q_7 . In the bias current test, the FET drivers, Q_8 and Q_9 , are switched by out of phase signals from Q_{10} and Q_{11} . This opens the FET switches Q_6 and Q_7 on alternate half cycles of the square wave output of the function generator. During the offset voltage, offset current test, the FET drivers are

operated synchronously from the output of Q_{11} . During the transfer function test, Q_6 and Q_7 are switched on continuously by turning off Q_{11} . R_{42} and R_{45} maintain the gates of the FET switches at zero gate to source voltage for maximum conductance during their on cycle. Since the sources of these switches are at the common mode input voltage of the device under test, these resistors are connected to the output of the common mode driver amplifier, A_8 .

The input for the integrator-feedback buffer, A_7 , is selected by the FET switches Q_4 and Q_5 . During the bias current and offset voltage offset current tests, A_7 is connected as an integrator and receives its input from the output of the device under test. The output of A_7 drives the feedback resistor, R_{40} . In this connection, the integrator holds the output of the device under test near ground and serves to amplify the voltages corresponding to bias current, offset current, and offset voltage by a factor of 1,000 before presenting them to the measurement system. FET switches Q_4 and Q_5 are turned on by switch section S_{1b} during these tests.

FET switches Q_4 and Q_5 are turned off during the transfer function test. This disconnects A_7 from the output of the device under test and changes it from an integrator to a non-inverting unity gain amplifier driven from the triangular wave output of the function generator through the attenuator R_{33} and R_{34} and switch section S_{1a} . In this connection, amplifier A_7 serves two functions; first, to provide an offset voltage correction to the input of the device under test and, second, to drive the input of the device under test with a ± 2.5 mV triangular wave centered about the offset voltage. During this test, the common mode driver amplifier is disabled by switch section S_{1a} and the vertical input of the measurement oscilloscope is transferred from the output of the integrator-buffer, A_7 , to the output of the device under test by switch section S_{1d} . S_{2a} allows supply voltages for the device under test to be set at ± 5 , ± 10 , ± 15 , or $\pm 20V$. S_{2b} changes the vertical scale factor for the measurement oscilloscope to maintain optimum vertical deflection for the particular power supply voltage used. S_4 is a momentary contact pushbutton switch which is used to change the load on the device under test from 10 k Ω to 2 k Ω .

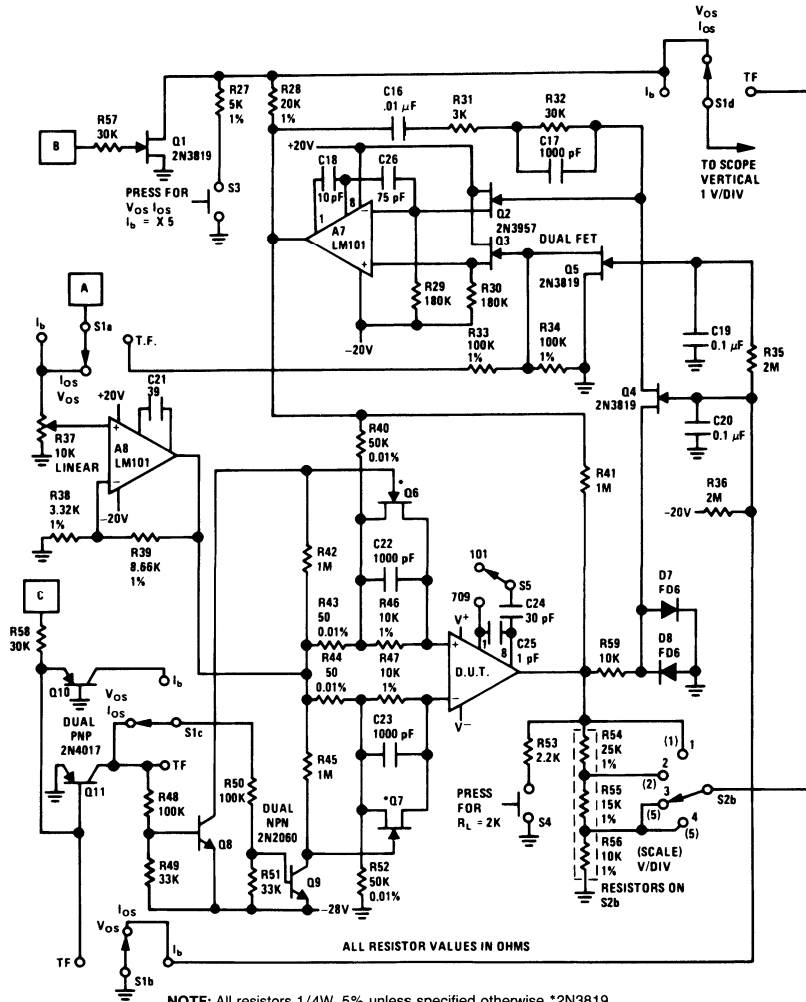
A delay must be provided when switching from the input tests to the transfer function tests. The purpose of this delay is to disable the integrator function of A_7 before driving it with the triangular wave. If this is not done, the offset correction voltage, stored on C_{16} , will be lost. This delay between opening FET switch Q_4 , and switch Q_5 , is provided by the RC filter, R_{35} and C_{19} .

Resistor R_{41} and diodes D_7 and D_8 are provided to control the integrator when no test device is present, or when a faulty test device is inserted. R_{41} provides a dc feedback path in the absence of a test device and resets the integrator to zero. Diodes D_7 and D_8 clamp the input to the integrator to approximately $\pm .7$ volts when a faulty device is inserted.

FET switch Q_1 and resistor R_{28} provide a ground reference at the beginning of the 50-ohm-source, offset-voltage trace. This trace provides a ground reference which is independent of instrument or oscilloscope calibration. The gate of Q_1 is driven by the output of monostable multivibrator A_5 , and shorts the vertical oscilloscope drive signal to ground during the time that A_5 output is positive.

Switch S_3 , R_{27} , and R_{28} provide a 5X scale increase during input parameter tests to allow measurement of amplifiers with large offset voltage, offset current, or bias current.

Switch S_5 allows amplifier compensation to be changed for 101 or 709 type amplifiers.



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FIGURE 7. Test Circuit

CALIBRATION

Calibration of the test system is relatively simple and requires only two adjustments. First, the output of the main regulator is set up for 20V. Then, the triangular wave generator is adjusted to provide $\pm 5V$ output by selecting R_{adj} . This sets the horizontal sweep for the X-Y oscilloscope used as the measurement system. The oscilloscope is then set up for 1V/division vertical and for a full 10 division horizontal sweep.

Scale factors for the three test positions are:

1. Bias Current Display (Figure 2)

I_{bias} total	100 nA/div. vertical
Common Mode Voltage	Variable horizontal

2. Offset Voltage-Offset Current (Figure 3)

I_{offset}	100 nA/div. vertical
V_{offset}	1 mV/div. vertical
Common Mode Voltage	Variable horizontal

3. Transfer Function (Figure 5)

V_{IN}	0.5 mV/div.
V_{OUT}	5V/div. @ $V_S \pm 20V$
	5V/div. @ $V_S \pm 15V$
	2V/div. @ $V_S \pm 10V$
	1V/div. @ $V_S \pm 5V$

$$\text{Gain} = \frac{\Delta V_{OUT}}{\Delta V_{IN}}$$

CONSTRUCTION

Test set construction is simplified through the use of integrated circuits and etched circuit layout.

Figure 8 gives photographs of the completed tester. Figure 9 shows the parts location for the components on the circuit board layout of Figure 10. An attempt should be made to

adhere to this layout to insure that parasitic coupling between elements will not cause oscillations or give calibration problems.

Table I is a listing of special components which are needed to fit the physical layout given for the tester.

TABLE I. Partial Parts List

T ₁	Triad F-90X
S ₁	Centralab PA2003 non-shorting
S ₂	Centralab PA2015 non-shorting

S₃, S₄ Grayhill 30-1 Series 30 subminiature pushbutton switch

S₅, S₆ Alcoswitch MST-105D SPDT

CONCLUSIONS

A semi-automatic test system has been described which will completely test the important operational amplifier parameters over the full power supply and common mode ranges. The system is simple, inexpensive, easily calibrated, and is equally suitable for engineering or quality assurance usage.

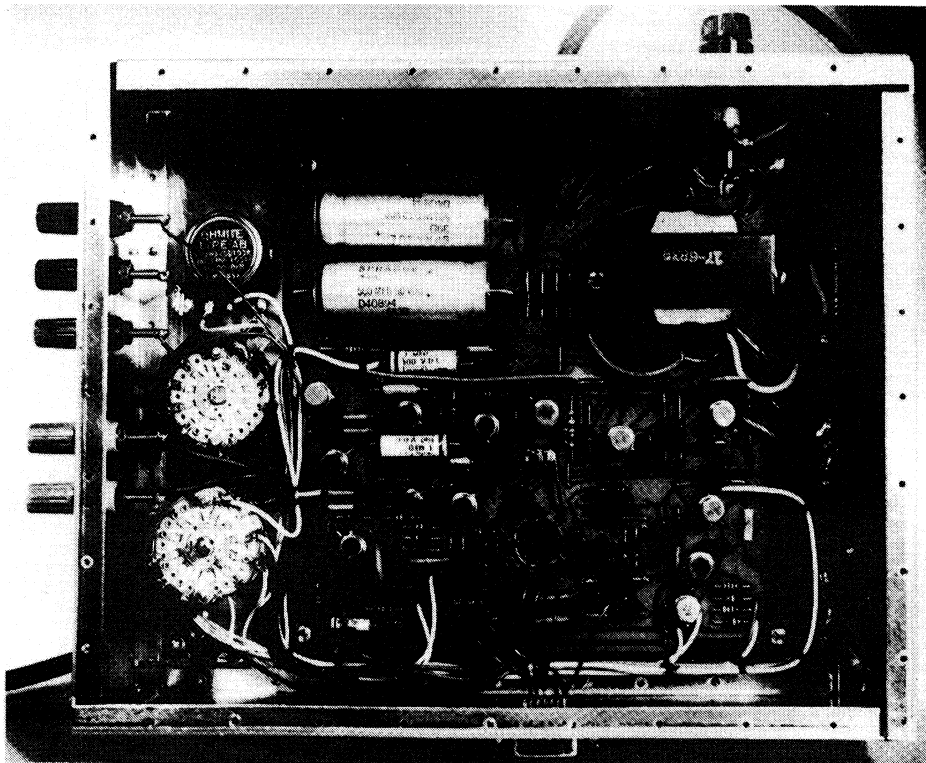


FIGURE 8a. Bottom of Test Set

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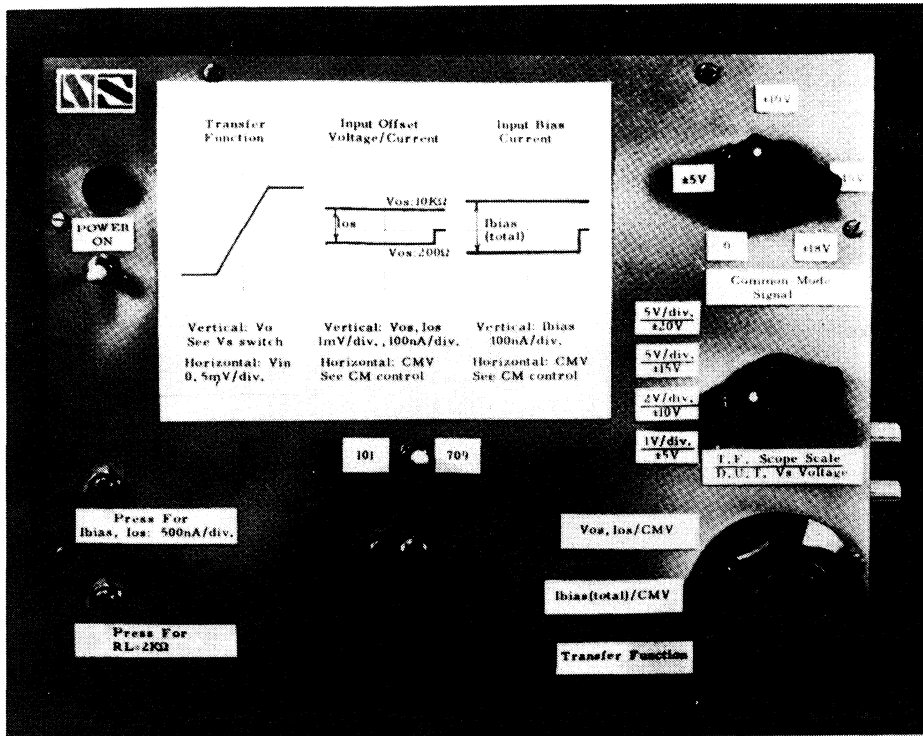


FIGURE 8b. Front Panel

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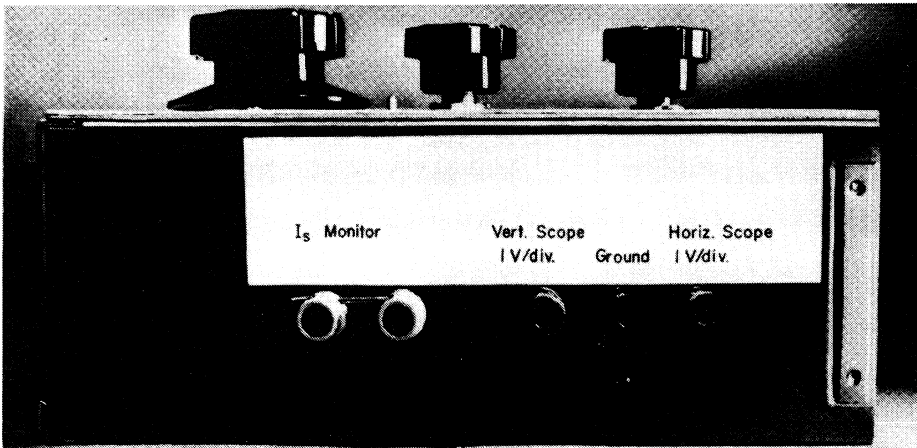


FIGURE 8c. Jacks

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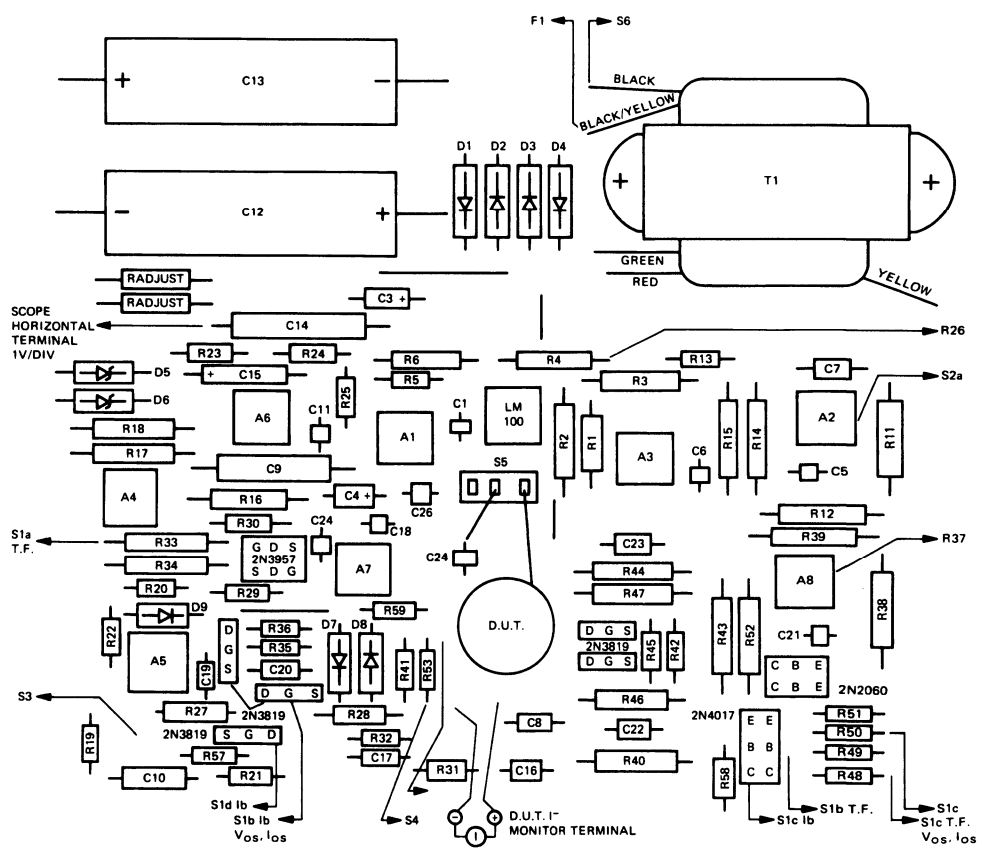


FIGURE 9. Component Location, Top View

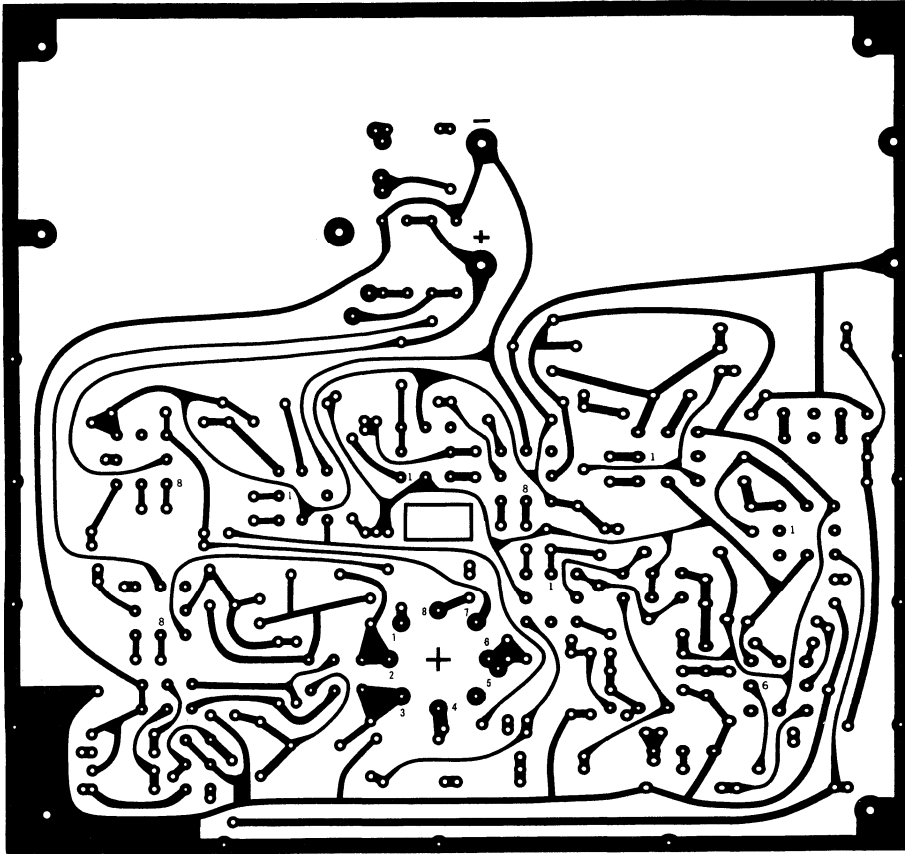


FIGURE 10. Circuit Board Layout

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IC Op Amp Beats FETs on Input Current

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abstract

A monolithic operational amplifier having input error currents in the order of 100 pA over a -55°C to 125°C temperature range is described. Instead of FETs, the circuit used bipolar transistors with current gains of 5000 so that offset voltage and drift are not degraded. A power consumption of 1 mW at low voltage is also featured.

A number of novel circuits that make use of the low current characteristics of the amplifier are given. Further, special design techniques required to take advantage of these low currents are explored. Component selection and the treatment of printed circuit boards is also covered.

introduction

A year ago, one of the loudest complaints heard about IC op amps was that their input currents were too high. This is no longer the case. Today ICs can provide the ultimate in performance for many applications—even surpassing FET amplifiers.

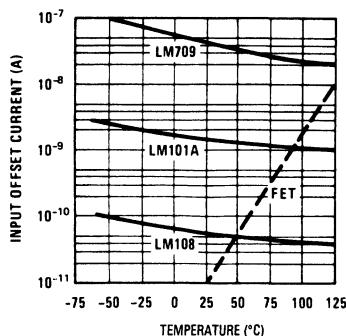
FET input stages have long been considered the best way to get low input currents in an op amp. Low-picoamp input currents can in fact be obtained at room temperature. However, this current, which is the leakage current of the gate junction, doubles every 10°C , so performance is severely degraded at high temperatures. Another disadvantage is that it is difficult to match FETs closely.¹ Unless expensive selection and trimming techniques are used, typical offset voltages of 50 mV and drifts of $50 \mu\text{V}/^{\circ}\text{C}$ must be tolerated.

Super gain transistors² are now challenging FETs. These devices are standard bipolar transistors which have been diffused for extremely high current gains. Typically, current gains of 5000 can be obtained at $1 \mu\text{A}$ collector currents. This makes it possible to get input currents which are competitive with FETs. It is also possible to operate these transistors at zero collector base voltage, eliminating the leakage currents that plague the FET. Hence they can provide lower error currents at elevated temperatures. As a bonus, super gain transistors match much better than FETs with typical offset voltages of 1 mV and drifts of $3 \mu\text{V}/^{\circ}\text{C}$.

Figure 1 compares the typical input offset currents of IC op amps and FET amplifiers. Although FETs give superior performance at room temperature, their advantage is rapidly lost as temperature increases. Still, they are clearly better than early IC amplifiers like the LM709.³ Improved devices, like the LM101A,⁴ equal FET performance over a -55°C to 125°C temperature range. Yet they use standard transistors in the input stage. Super gain transistors can provide more than an order of magnitude improvement over the LM101A. The LM108 uses these to equal FET performance over a 0°C to 70°C temperature range.

In applications involving 125°C operation, the LM108 is about two orders of magnitude better than FETs. In fact, unless special precautions are taken, overall circuit performance is often limited by leakages in capacitors, diodes, ana-

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Application Note 29



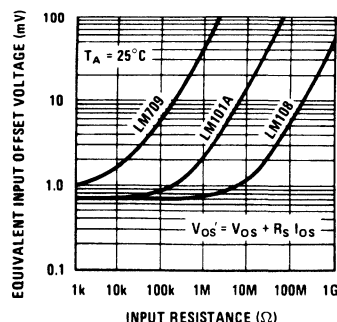
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Figure 1. Comparing IC op amps with FET-input amplifier

log switches or printed circuit boards, rather than by the op amp itself.

effects of error current

In an operational amplifier, the input current produces a voltage drop across the source resistance, causing a dc error. This effect can be minimized by operating the amplifier with equal resistances on the two inputs.⁵ The error is then proportional to the difference in the two input currents, or the offset current. Since the current gains of monolithic transistors tend to match well, the offset current is typically a factor of ten less than the input currents.

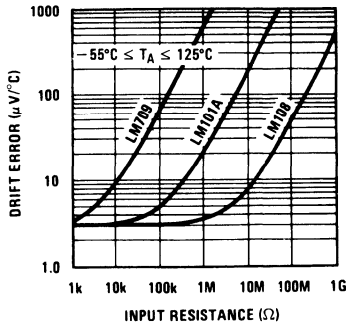


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Figure 2. Illustrating the effect of source resistance on typical input error voltage

Naturally, error current has the greatest effect in high impedance circuitry. Figure 2 illustrates this point. The offset voltage of the LM709 is degraded significantly with source resistances greater than $10 \text{ k}\Omega$. With the LM101A this is extended to source resistances high as $500 \text{ k}\Omega$. The LM108, on the other hand, works well with source resistances above $10 \text{ M}\Omega$.

High source resistances have an even greater effect on the drift of an amplifier, as shown in *Figure 3*. The performance of the LM709 is worsened with sources greater than 3 k Ω . The LM101A holds out to 100 k Ω sources, while the LM108 still works well at 3 M Ω .



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Figure 3. Degradation of typical drift characteristics with high source resistances

It is difficult to include FET amplifiers in *Figure 3* because their drift is initially $50 \mu\text{V}/^\circ\text{C}$, unless they are selected and trimmed. Even though their drift may be well controlled ($5 \mu\text{V}/^\circ\text{C}$) over a limited temperature range, trimmed amplifiers generally exhibit a much higher drift over a -55°C to 125°C temperature range. At any rate, their average drift rate would, at best, be like that of the LM101A where 125°C operation is involved.

Applications that require low error currents include amplifiers for photodiodes or capacitive transducers, as these usually operate at megohm impedance levels. Sample-and-hold-circuits, timers, integrators and analog memories also benefit from low error currents. For example, with the LM709, worst case drift rates for these kinds of circuits is in the order of 1.5 V/sec. The LM108 improves this to 3 mV/sec.—worst case over a -55°C to 125°C temperature range. Low input currents are also helpful in oscillators and active filters to get low frequency operation with reasonable capacitor values. The LM108 can be used at a frequency of 1 Hz with capacitors no larger than $0.01 \mu\text{F}$. In logarithmic amplifiers, the dynamic range can be extended by nearly 60 dB by going from the LM709 to the LM108. In other applications, having low error currents often permits an entirely different design approach which can greatly simplify circuitry.

the LM108

Figure 4 shows a simplified schematic of the LM108. Two kinds of NPN transistors are used on the IC chip: super gain (primary) transistors which have a current gain of 5000 with a breakdown voltage of 4V and conventional (secondary) transistors which have a current gain of 200 with an 80V breakdown. These are differentiated on the schematic by drawing the secondaries with a wider base.

Primary transistors (Q_1 and Q_2) are used for the input stage; and they are operated in a cascode connection with Q_5 and Q_6 . The bases of Q_5 and Q_6 are bootstrapped to the emitters of Q_1 and Q_2 through Q_3 and Q_4 , so that the input transistors are operated at zero collector-base voltage. Hence, circuit performance is not impaired by the low breakdown of the primaries, as the secondary transistors stand

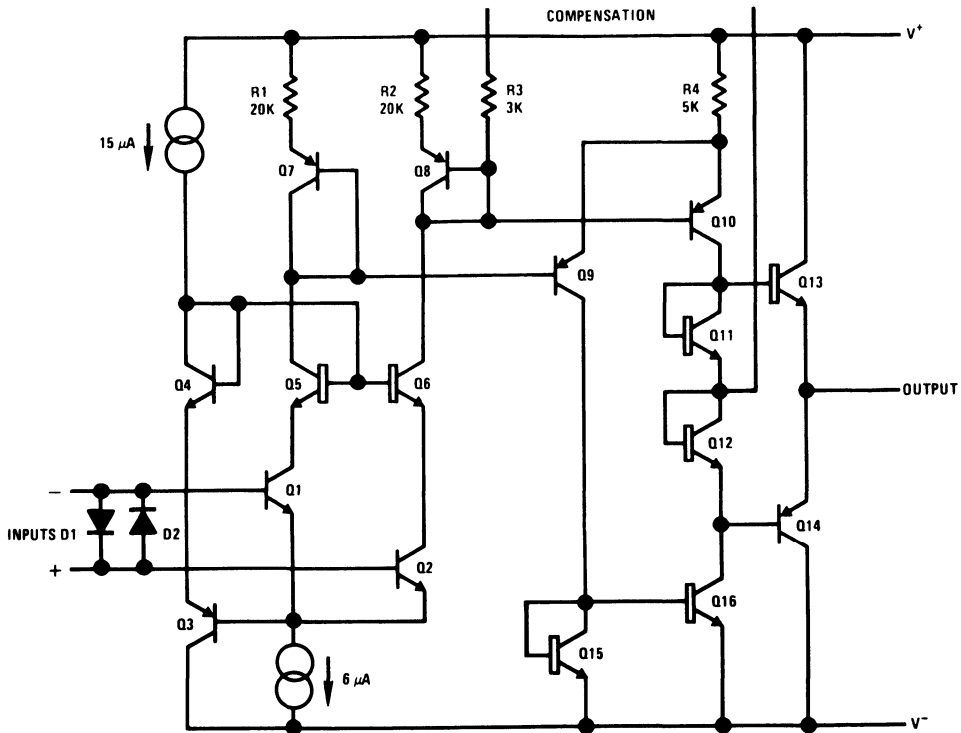


Figure 4. Simplified schematic of the LM108

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off the common mode voltage. This configuration also improves the common mode rejection since the input transistors do not see variations in the common mode voltage. Further, because there is no voltage across their collector-base junctions, leakage currents in the input transistors are effectively eliminated.

The second stage is a differential amplifier using high gain lateral PNPs (Q_9 and Q_{10}).⁶ These devices have current gains of 150 and a breakdown voltage of 80V. R_1 and R_2 are the collector load resistors for the input stage. Q_7 and Q_8 are diode connected laterals which compensate for the emitter-base voltage of the second stage so that its operating current is set at twice that of the input stage by R_4 .

The second stage uses an active collector load (Q_{15} and Q_{16}) to obtain high gain. It drives a complementary class-B output stage which gives a substantial load driving capability. The dead zone of the output stage is eliminated by biasing it on the verge of conduction with Q_{11} and Q_{12} .

Two methods of frequency compensation are available for the amplifier. In one a 30 pF capacitor is connected from the input to the output of the second stage (between the compensation terminals). This method is pin-compatible with the LM101 or LM101A. It can also be compensated by connecting a 100 pF capacitor from the output of the second stage to ground. This technique has the advantage of improving the high frequency power supply rejection by a factor of ten.

A complete schematic of the LM108 is given in the Appendix along with a description of the circuit. This includes such essential features as overload protection for the inputs and outputs.

performance

The primary design objective for the LM108 was to obtain very low input currents without sacrificing offset voltage or drift. A secondary objective was to reduce the power consumption. Speed was of little concern, as long as it was comparable with the LM709. This is logical as it is quite difficult to make high-impedance circuits fast; and low power circuits are very resistant to being made fast. In other respects, it was desirable to make the LM108 as much like the LM101A as possible.

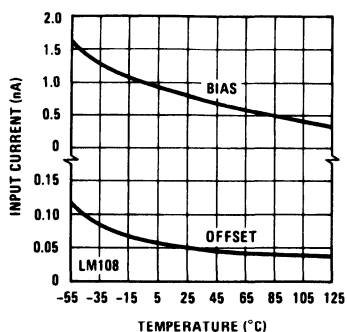


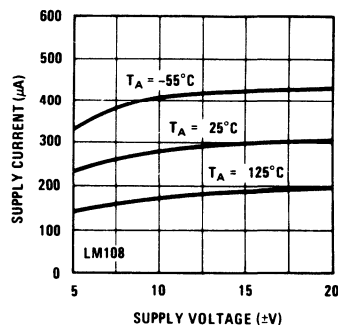
Figure 5. Input currents

Figure 5 shows the input current characteristics of the LM108 over a -55°C to 125°C temperature range. Not only are the input currents low, but also they do not change radically over temperature. Hence, the device lends itself to relatively simple temperature compensation schemes, that will be described later.

There has been considerable discussion about using Darlington input stages rather than super gain transistors to obtain low input currents.^{6,7} It is appropriate to make a few comments about that here.

Darlington inputs can give about the same input bias currents as super gain transistors—at room temperature. However, the bias current varies as the square of the transistor current gain. At low temperatures, super gain devices have a decided advantage. Additionally, the offset current of super gain transistors is considerably lower than Darlington's, when measured as a percentage of bias current. Further, the offset voltage and offset voltage drift of Darlington transistors is both higher and more unpredictable.

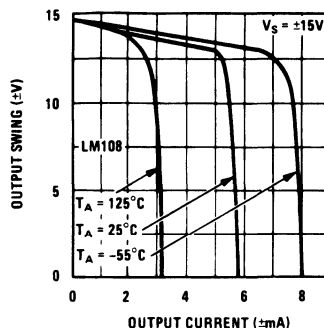
Experience seems to tell the real truth about Darlington's. Quite a few op amps with Darlington input stages have been introduced. However, none have become industry standards. The reason is that they are more sensitive to variations in the manufacturing process. Therefore, satisfactory performance specifications can only be obtained by sacrificing the manufacturing yield.



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Figure 6. Supply current

The supply current of the LM108 is plotted as a function of supply voltage in Figure 6. The operating current is about an order of magnitude lower than devices like the LM709. Furthermore, it does not vary radically with supply voltage which means that the device performance is maintained at low voltages and power consumption is held down at high voltages.

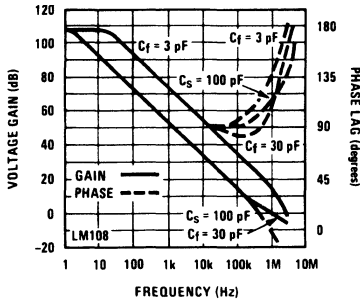


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Figure 7. Output swing

The output drive capability of the circuit is illustrated in Figure 7. The output swings to within a volt of the supplies,

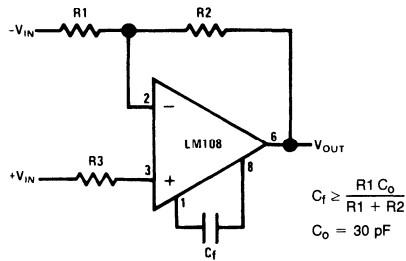
which is especially important when operating at low voltages. The output falls off rapidly as the current increases above a certain level and the short circuit protection goes into effect. The useful output drive is limited to about ± 2 mA. It could have been increased by the addition of Darlington transistors on the output, but this would have restricted the voltage swing at low supply voltages. The amplifier, incidentally, works with common mode signals to within a volt of the supplies so it can be used with supply voltages as low as ± 2 V.



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Figure 8. Open loop frequency response

The open loop frequency response, plotted in Figure 8, indicates that the frequency response is about the same as that of the LM709 or the LM101A. Curves are given for the two compensation circuits shown in Figure 9. The standard compensation is identical to that of the LM101 or LM101A. The alternate compensation scheme gives much better rejection of high frequency power supply noise, as will be shown later.

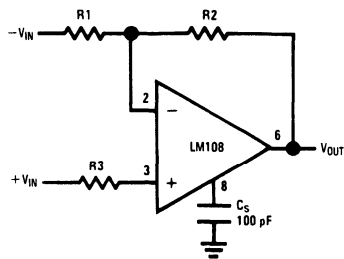


$$C_f \geq \frac{R_1 C_o}{R_1 + R_2}$$

$$C_o = 30 \text{ pF}$$

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a. standard compensation circuit



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b. alternate compensation circuit

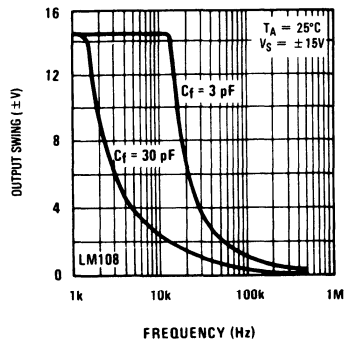
Figure 9. Compensation circuits

With unity gain compensation, both methods give a 75-degree stability margin. However, the shunt compensation has a 300 kHz small signal bandwidth as opposed to 1 MHz for the other scheme. Because the compensation capacitor is not included on the IC chip, it can be tailored to fit the application. When the amplifier is used only at low frequencies, the compensation capacitor can be increased to give a greater stability margin. This makes the circuit less sensitive to capacitive loading, stray capacitances or improper supply bypassing. Overcompensating also reduces the high frequency noise output of the amplifier.

With closed-loop gains greater than one, the high frequency performance can be optimized by making the compensation capacitor smaller. If unity-gain compensation is used for an amplifier with a gain of ten, the gain error will exceed 1-percent at frequencies above 400 Hz. This can be extended to 4 kHz by reducing the compensation capacitor to 3 pF. The formula for determining the minimum capacitor value is given in Figure 9a. It should be noted that the capacitor value does not really depend on the closed-loop gain. Instead, it depends on the high frequency attenuation in the feedback networks and, therefore, the values of R_1 and R_2 . When it is desirable to optimize performance at high frequencies, the standard compensation should be used. With small capacitor values, the stability margin obtained with shunt compensation is inadequate for conservative designs.

The frequency response of an operational amplifier is considerably different for large output signals than it is for small signals. This is indicated in Figure 10. With unity-gain compensation, the small signal bandwidth of the LM108 is 1 MHz. Yet full output swing cannot be obtained above 2 kHz. This corresponds to a slew rate of $0.3 \text{ V}/\mu\text{s}$. Both the full-output bandwidth and the slew rate can be increased by using smaller compensation capacitors, as is indicated in the figure. However, this is only applicable for higher closed loop gains. The results plotted in Figure 10 are for standard compensations. With unity gain compensation, the same curves are obtained for the shunt compensation scheme.

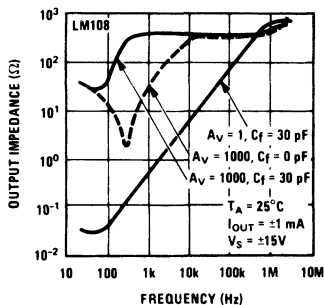
Classical op amp theory establishes output resistance as an important design parameter. This is not true for IC op amps: The output resistance of most devices is low enough that it can be ignored, because they use class-B output stages. At low frequencies, thermal feedback between the output and



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Figure 10. Large signal frequency response

input stages determines the effective output resistance, and this cannot be accounted for by conventional design theories. Semiconductor manufacturers take care of this by specifying the gain under full load conditions, which combines output resistance with gain as far as it affects overall circuit performance. This avoids the fictitious problem that can be created by an amplifier with infinite gain, which is good, that will cause the open loop output resistance to appear infinite, which is bad, although none of this affects overall performance significantly.



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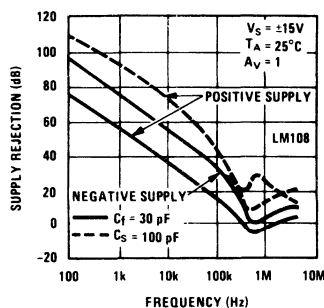
Figure 11. Closed loop output impedance

The *closed loop* output impedance is, nonetheless, important in some applications. This is plotted for several operating conditions in *Figure 11*. It can be seen that the output impedance rises to about 500Ω at high frequencies. The increase occurs because the compensation capacitor rolls off the open loop gain. The output resistance can be reduced at the intermediate frequencies, for closed loop gains greater than one, by making the capacitor smaller. This is made apparent in the figure by comparing the output resistance with and without frequency compensation for a closed loop gain of 1000.

The output resistance also tends to increase at low frequencies. Thermal feedback is responsible for this phenomenon. The data for *Figure 11* was taken under large-signal conditions with $\pm 15V$ supplies, the output at zero and ± 1 mA current swing. Hence, the thermal feedback is accentuated more than would be the case for most applications.

In an op amp, it is desirable that performance be unaffected by variations in supply voltage. IC amplifiers are generally better than discrete in this respect because it is necessary for one single design to cover a wide range of uses. The LM108 has a power supply rejection which is typically in excess of 100 dB, and it will operate with supply voltages from $\pm 2V$ to $\pm 20V$. Therefore, well-regulated supplies are unnecessary, for most applications, because a 20-percent variation has little effect on performance.

The story is different for high-frequency noise on the supplies, as is evident from *Figure 12*. Above 1 MHz, practically all the noise is fed through to the output. The figure also demonstrates that shunt compensation is about ten times better at rejecting high frequency noise than is standard compensation. This difference is even more pronounced with larger capacitor values. The shunt compensation has the added advantage that it makes the circuit virtually unaffected by the lack of supply bypassing.



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Figure 12. Power supply rejection

Power supply rejection is defined as the ratio of the change in offset voltage to the change in the supply voltage producing it. Using this definition, the rejection at low frequencies is unaffected by the closed loop gain. However, at high frequencies, the opposite is true. The high frequency rejection is increased by the closed loop gain. Hence, an amplifier with a gain of ten will have an order of magnitude better rejection than that shown in *Figure 12* in the vicinity of 100 kHz to 1 MHz.

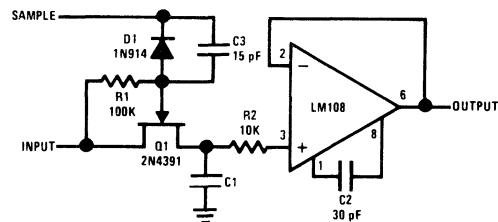
The overall performance of the LM108 is summarized in Table I*. It is apparent from the table and the previous discussion that the device is ideally suited for applications that require low input currents or reduced power consumption. The speed of the amplifier is not spectacular, but this is not usually a problem in high-impedance circuitry. Further, the reduced high frequency performance makes the amplifier easier to use in that less attention need be paid to capacitive loading, stray capacitances and supply bypassing.

applications

Because of its low input current the LM108 opens up many new design possibilities. However, extra care must be taken in component selection and the assembly of printed circuit boards to take full advantage of its performance. Further, unusual design techniques must often be applied to get around the limitations of some components.

sample and hold circuits

The holding accuracy of a sample and hold is directly related to the error currents in the components used. Therefore, it is a good circuit to start off with in explaining the problems



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Figure 13. Sample and hold circuit

involved. *Figure 13* shows one configuration for a sample and hold. During the sample interval, Q_1 is turned on, charging the hold capacitor, C_1 , up to the value of the input signal.

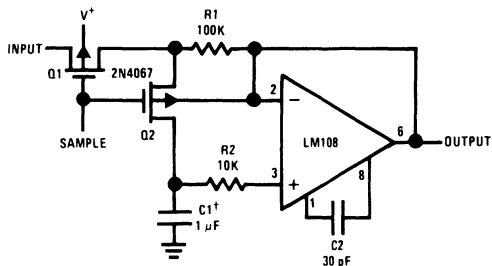
*See Appendix Heading in This Application Note.

When Q_1 is turned off, C_1 retains this voltage. The output is obtained from an op amp that buffers the capacitor so that it is not discharged by any loading. In the holding mode, an error is generated as the capacitor loses charge to supply circuit leakages. The accumulation rate for error is given by

$$\frac{dV}{dt} = \frac{I_E}{C_1}$$

where dV/dt is the time rate of change in output voltage and I_E is the sum of the input current to the op amp, the leakage current of the holding capacitor, board leakages and the "off" current of the FET switch.

When high-temperature operation is involved, the FET leakage can limit circuit performance. This can be minimized by using a junction FET, as indicated, because commercial junction FETs have lower leakage than their MOS counterparts. However, at 125°C even junction devices are a problem. Mechanical switches, such as reed relays, are quite satisfactory from the standpoint of leakage. However, they are often undesirable because they are sensitive to vibration, they are too slow or they require excessive drive power. If this is the case, the circuit in *Figure 14* can be used to eliminate the FET leakage.



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†Teflon, polyethylene or polycarbonate dielectric capacitor

Worst case drift less than 3 mV/sec

Figure 14. Sample and hold that eliminates leakage in FET switches

When using P-channel MOS switches, the substrate must be connected to a voltage which is always more positive than the input signal. The source-to-substrate junction becomes forward biased if this is not done. The troublesome leakage current of a MOS device occurs across the substrate-to-drain junction. In *Figure 14*, this current is routed to the output of the buffer amplifier through R_1 so that it does not contribute to the error current.

The main sample switch is Q_1 , while Q_2 isolates the hold capacitor from the leakage of Q_1 . When the sample pulse is applied, both FETs turn on charging C_1 to the input voltage. Removing the pulse shuts off both FETs, and the output leakage of Q_1 goes through R_1 to the output. The voltage drop across R_1 is less than 10 mV, so the substrate of Q_2 can be bootstrapped to the output of the LM108. Therefore, the voltage across the substrate-drain junction is equal to the offset voltage of the amplifier. At this low voltage, the leakage of the FET is reduced by about two orders of magnitude.

It is necessary to use MOS switches when bootstrapping the leakages in this fashion. The gate leakage of a MOS device is still negligible at high temperatures; this is not the case with junction FETs. If the MOS transistors have protec-

tive diodes on the gates, special arrangements must be made to drive Q_2 so the diode does not become forward biased.

In selecting the hold capacitor, low leakage is not the only requirement. The capacitor must also be free of dielectric polarization phenomena.⁸ This rules out such types as paper, mylar, electrolytic, tantalum or high-K ceramic. For small capacitor values, glass or silvered-mica capacitors are recommended. For the larger values, ones with teflon, polyethylene or polycarbonate dielectrics should be used.

The low input current of the LM108 gives a drift rate, in hold, of only 3 mV/sec when a 1 μ F hold capacitor is used. And this number is worst case over the military temperature range. Even if this kind of performance is not needed, it may still be beneficial to use the LM108 to reduce the size of the hold capacitor. High quality capacitors in the larger sizes are bulky and expensive. Further, the switches must have a low "on" resistance and be driven from a low impedance source to charge large capacitors in a short period of time.

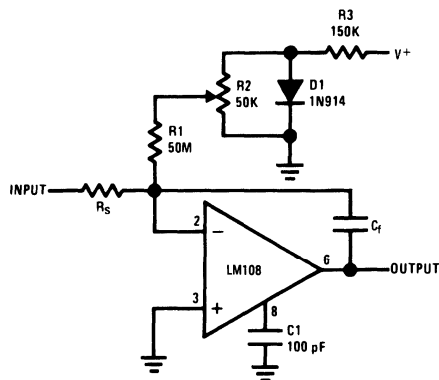
If the sample interval is less than about 100 μ s, the LM108 may not be fast enough to work properly. If this is the case, it is advisable to substitute the LM102A,⁹ which is a voltage follower designed for both low input current and high speed. It has a 30 V/ μ s slew rate and will operate with sample intervals as short as 1 μ s.

When the hold capacitor is larger than 0.05 μ F, an isolation resistor should be included between the capacitor and the input of the amplifier (R_2 in *Figure 14*). This resistor insures that the IC will not be damaged by shorting the output or abruptly shutting down the supplies when the capacitor is charged. This precaution is not peculiar to the LM108 and should be observed on any IC op amp.

integrators

Integrators are a lot like sample-and-hold circuits and have essentially the same design problems. In an integrator, a capacitor is used as a storage element; and the error accumulation rate is again proportional to the input current of the op amp.

Figure 15 shows a circuit that can compensate for the bias current of the amplifier. A current is fed into the summing node through R_1 to supply the bias current. The potentiometer, R_2 , is adjusted so that this current exactly equals the bias current, reducing the drift rate to zero.



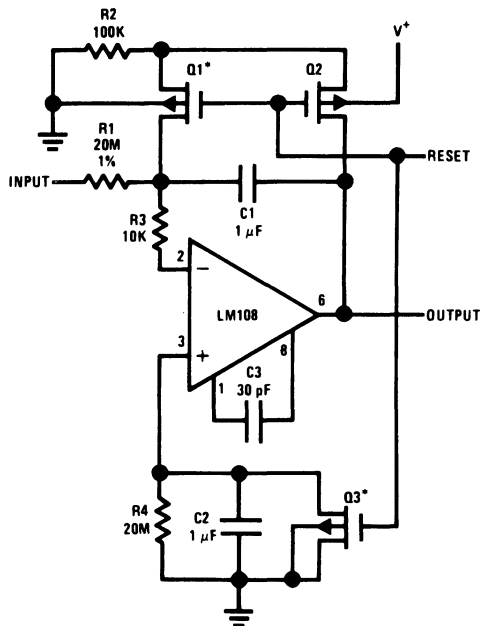
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Figure 15. Integrator with bias current compensation

The diode is used for two reasons. First, it acts as a regulator, making the compensation relatively insensitive to variations in supply voltage. Secondly, the temperature drift of diode voltage is approximately the same as the temperature drift of bias current. Therefore, the compensation is more effective if the temperature changes. Over a 0°C to 70°C temperature range, the compensation will give a factor of ten reduction in input current. Even better results are achieved if the temperature change is less.

Normally, it is necessary to reset an integrator to establish the initial conditions for integration. Resetting to zero is readily accomplished by shorting the integrating capacitor with a suitable switch. However, as with the sample and hold circuits, semiconductor switches can cause problems because of high-temperature leakage.

A connection that gets rid of switch leakages is shown in *Figure 16*. A negative-going reset pulse turns on Q_1 and Q_2 ,



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* Q_1 and Q_3 should not have internal gate-protection diodes.

Figure 16. Low drift integrator with reset

shorting the integrating capacitor. When the switches turn off, the leakage current of Q_2 is absorbed by R_2 while Q_1 isolates the output of Q_2 from the summing node. Q_1 has practically no voltage across its junctions because the substrate is grounded; hence, leakage currents are negligible.

The additional circuitry shown in *Figure 16* makes the error accumulation rate proportional to the offset current, rather than the bias current. Hence, the drift is reduced by roughly a factor of 10. During the integration interval, the bias current of the non-inverting input accumulates an error across R_4 and C_2 just as the bias current on the inverting input does across R_1 and C_1 . Therefore, if R_4 is matched with R_1 and C_2 is matched with C_1 (within about 5 percent) the output will drift at a rate proportional to the difference in these

currents. At the end of the integration interval, Q_3 removes the compensating error accumulated on C_2 as the circuit is reset.

In applications involving large temperature changes, the circuit in *Figure 16* gives better results than the compensation scheme in *Figure 15*—especially under worst case conditions. Over a -55°C to 125°C temperature range, the worst case drift is reduced from 3 mV/sec to 0.5 mV/sec when a $1\ \mu\text{F}$ integrating capacitor is used. If this reduction in drift is not needed, the circuit can be simplified by eliminating R_4 , C_2 and Q_3 and returning the non-inverting input of the amplifier directly to ground.

In fabricating low drift integrators, it is again necessary to use high quality components and minimize leakage currents in the wiring. The comments made on capacitors in connection with the sample-and-hold circuits also apply here. As an additional precaution, a resistor should be used to isolate the inverting input from the integrating capacitor if it is larger than $0.05\ \mu\text{F}$. This resistor prevents damage that might occur when the supplies are abruptly shut down while the integrating capacitor is charged.

Some integrator applications require both speed and low error current. The output amplifiers for photomultiplier tubes or solid-state radiation detectors are examples of this. Although the LM108 is relatively slow, there is a way to speed it up when it is used as an inverting amplifier. This is shown in *Figure 17*.

The circuit is arranged so that the high-frequency gain characteristics are determined by A_2 , while A_1 determines the dc and low-frequency characteristics. The non-inverting input of A_1 is connected to the summing node through R_1 . A_1 is operated as an integrator, going through unity gain at 500 Hz. Its output drives the non-inverting input of A_2 . The inverting input of A_2 is also connected to the summing node through C_3 . C_3 and R_3 are chosen to roll off below 750 Hz. Hence, at frequencies above 750 Hz, the feedback path is directly around A_2 , with A_1 contributing little. Below 500 Hz, however, the direct feedback path to A_2 rolls off; and the gain of A_1 is added to that of A_2 .

The high gain frequency amplifier, A_2 , is an LM101A connected with feed-forward compensation.¹⁰ It has a 10 MHz equivalent small-signal bandwidth, a $10\text{V}/\mu\text{s}$ slew rate and a 250 kHz large-signal bandwidth, so these are the high-frequency characteristics of the complete amplifier. The bias current of A_2 is isolated from the summing node by C_3 . Hence, it does not contribute to the dc drift of the integrator. The inverting input of A_1 is the only dc connection to the summing junction. Therefore, the error current of the composite amplifier is equal to the bias current of A_1 .

If A_2 is allowed to saturate, A_1 will then start towards saturation. If the output of A_1 gets far off zero, recovery from saturation will be slowed drastically. This can be prevented by putting zener clamp diodes across the integrating capacitor. A suitable clamping arrangement is shown in *Figure 17*. D_1 and D_2 are included in the clamp circuit along with R_5 to keep the leakage currents of the zeners from introducing errors.

In addition to increasing speed, this circuit has other advantages. For one, it has the increased output drive capability of the LM101A. Further, thermal feedback is virtually eliminated because the LM108 does not see load variations. Lastly, the open loop gain is nearly infinite at low frequencies as it is the product of the gains of the two amplifiers.

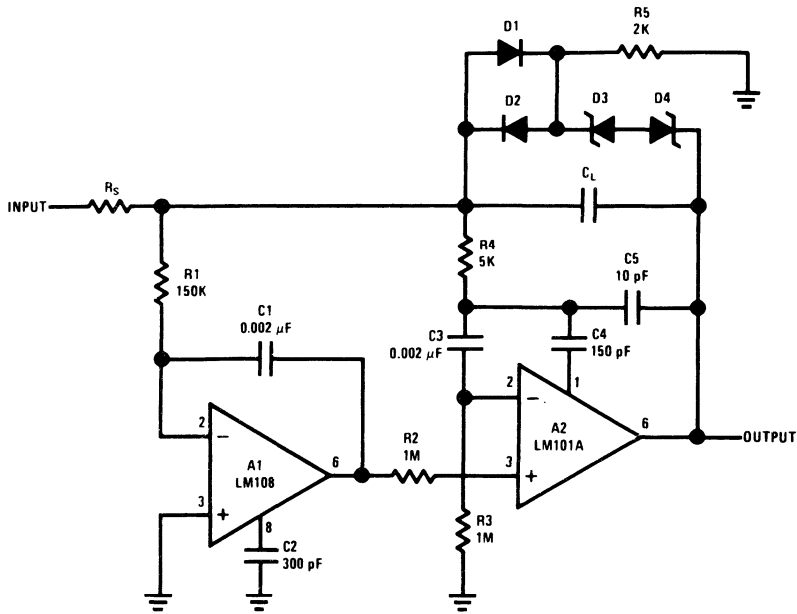


Figure 17. Fast integrator

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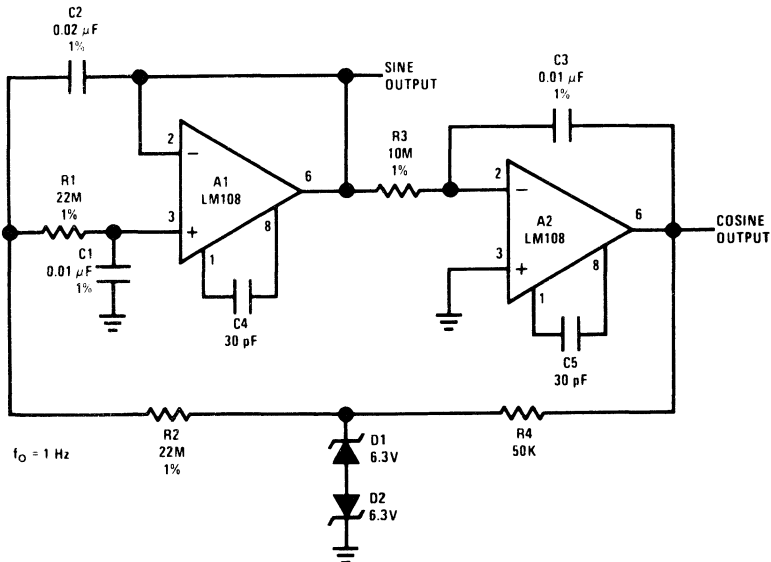


Figure 18. Sine wave oscillator

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sine wave oscillator

Although it is comparatively easy to build an oscillator that approximates a sine wave, making one that delivers a high-purity sinusoid with a stable frequency and amplitude is another story. Most satisfactory designs are relatively complicated and require individual trimming and temperature compensation to make them work. In addition, they generally take a long time to stabilize to the final output amplitude.

A unique solution to most of these problems is shown in *Figure 18*. A₁ is connected as a two-pole low-pass active filter, and A₂ is connected as an integrator. Since the ultimate phase lag introduced by the amplifiers is 270 degrees, the circuit can be made to oscillate if the loop gain is high enough at the frequency where the lag is 180 degrees. The gain is actually made somewhat higher than is required for oscillation to insure starting. Therefore, the amplitude builds up until it is limited by some nonlinearity in the system.

Amplitude stabilization is accomplished with zener clamp diodes, D_1 and D_2 . This does introduce distortion, but it is reduced by the subsequent low pass filters. If D_1 and D_2 have equal breakdown voltages, the resulting symmetrical clipping will virtually eliminate the even-order harmonics. The dominant harmonic is then the third, and this is about 40 dB down at the output of A_1 and about 50 dB down on the output of A_2 . This means that the total harmonic distortion on the two outputs is 1 percent and 0.3 percent, respectively.

The frequency of oscillation and the oscillation threshold are determined by R_1 , R_2 , R_3 , C_1 , C_2 and C_3 . Therefore precision components with low temperature coefficients should be used. If R_3 is made lower than shown, the circuit will accept looser component tolerances before dropping out of oscillation. The start up will also be quicker. However, the price paid is that distortion is increased. The value of R_4 is not critical, but it should be made much smaller than R_2 so that the effective resistance at R_2 does not drop when the clamp diodes conduct.

The output amplitude is determined by the breakdown voltages of D_1 and D_2 . Therefore, the clamp level should be temperature compensated for stable operation. Diode-connected (collector shorted to base) NPN transistors with an emitter-base breakdown of about 6.3V work well, as the positive temperature coefficient of the diode in reverse breakdown nearly cancels the negative temperature coefficient of the forward-biased diode. Added advantages of using transistors are that they have less shunt capacitance and sharper breakdowns than conventional zeners.

The LM108 is particularly useful in this circuit at low frequencies, since it permits the use of small capacitors. The circuit shown oscillates at 1 Hz, but uses capacitors in the order of 0.01 μ F. This makes it much easier to find temperature-stable precision capacitors. However, some judgment must be used as large value resistors with low temperature coefficients are not exactly easy to come by.*

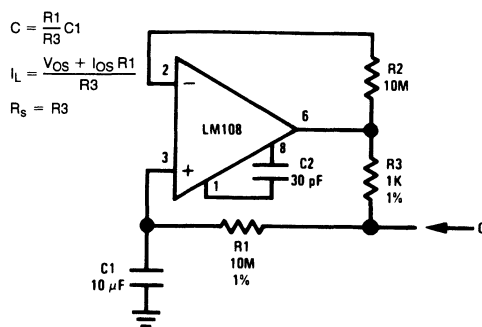
The LM108s are useful in this circuit for output frequencies up to 1 kHz. Beyond that, better performance can be realized by substituting an LM102A for A_1 and an LM101A with feed-forward compensation for A_2 . The improved high-frequency response of these devices extend the operating frequency out to 100 kHz.

capacitance multiplier

Large capacitor values can be eliminated from most systems just by raising the impedance levels, if suitable op amps are available. However, sometimes it is not possible because the impedance levels are already fixed by some element of the system like a low impedance transducer. If this is the case, a capacitance multiplier can be used to increase the effective capacitance of a small capacitor and couple it into a low impedance system.

Previously, IC op amps could not be used effectively as capacitance multipliers because the equivalent leakages generated due to offset current were significantly greater than the leakages of large tantalum capacitors. With the LM108, this has changed. The circuit shown in *Figure 19* generates an equivalent capacitance of 100,000 μ F with a worst case leakage of 8 μ A—over a -55°C to 125°C temperature range.

*Large-value resistors are available from Victoreen Instrument, Cleveland, Ohio and Pyrofilm Resistor Co., Whippany, New Jersey.



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Figure 19. Capacitance multiplier

The performance of the circuit is described by the equations given in *Figure 19*, where C is the effective output capacitance, I_L is the leakage current of this capacitance and R_S is the series resistance of the multiplied capacitance. The series resistance is relatively high, so high-Q capacitors cannot be realized. Hence, such applications as tuned circuits and filters are ruled out. However, the multiplier can still be used in timing circuits or servo compensation networks where some resistance is usually connected in series with the capacitor or the effect of the resistance can be compensated for.

One final point is that the leakage current of the multiplied capacitance is not a function of the applied voltage. It persists even with no voltage on the output. Therefore, it can generate offset errors in a circuit, rather than the scaling errors caused by conventional capacitors.

instrumentation amplifier

In many instrumentation applications there is frequently a need for an amplifier with a high-impedance differential input and a single ended output. Obvious uses for this are amplifiers for bridge-type signal sources such as strain gages, temperature sensors or pressure transducers. General purpose op amps have satisfactory input characteristics, but feedback must be added to determine the effective gain. And the addition of feedback can drastically reduce the input resistance and degrade common mode rejection.

Figure 20 shows the classical op amp circuit for a differential amplifier. This circuit has three main disadvantages. First, the input resistance on the inverting input is relatively low, being equal to R_1 . Second, there usually is a large difference in the input resistance of the two inputs, as is indicated by the equations on the schematic. Third, the common mode rejection is greatly affected by resistor matching and by balancing of the source resistances. A 1-percent deviation in any one of the resistor values reduces the common mode rejection to 46 dB for a closed loop gain of 1, to 60 dB for a gain of 10 and to 80 dB for a gain of 100.

Clearly, the only way to get high input impedance is to use very large resistors in the feedback network. The op amp must operate from a source resistance which is orders of magnitude larger than the resistance of the signal source. Older IC op amps introduced excessive offset and drift when operating from higher resistances and could not be used successfully. The LM108, however, is relatively unaffected by the large resistors, so this approach can sometimes be employed.

With large input resistors, the feedback resistors, R_3 and R_4 , can get quite large for higher closed loop gains. For example, if R_1 and R_2 are 1 M Ω , R_3 and R_4 must be 100 M Ω for a gain of 100. It is difficult to accurately match resistors that are this high in value, so common mode rejection may suffer. Nonetheless, any one of the resistors can be trimmed to take out common mode feedthrough caused either by resistors mismatches or the amplifier itself.

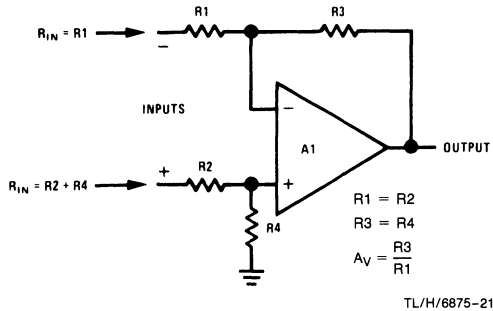


Figure 20. Feedback connection for a differential amplifier

Another problem caused by large feedback resistors is that stray capacitance can seriously affect the high frequency common mode rejection. With 1 M Ω input resistors, a 1 pF mismatch in stray capacitance from either input to ground can drop the common mode rejection to 40 dB at 1500 Hz. The high frequency rejection can be improved at the expense of frequency response by shunting R_3 and R_4 with matched capacitors.

With high impedance bridges, the feedback resistances become prohibitively large even for the LM108, so the circuit in *Figure 20* cannot be used. One possible alternative is shown in *Figure 21*. R_2 and R_3 are chosen so that their equivalent parallel resistance is equal to R_1 . Hence, the output of the amplifier will be zero when the bridge is balanced.

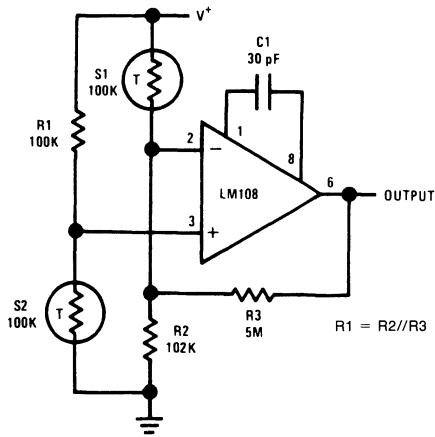


Figure 21. Amplifier for bridge transducers

When the bridge goes off balance, the op amp maintains the voltage between its input terminals at zero with current fed back from the output through R_3 . This circuit does not act like a true differential amplifier for large imbalances in the bridge. The voltage drops across the two sensor resistors, S_1 and S_2 , become unequal as the bridge goes off balance, causing some non-linearity in the transfer function. However, this is not usually objectionable for small signal swings.

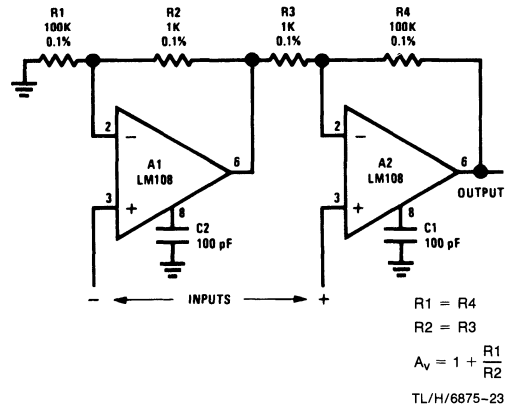


Figure 22. Differential input instrumentation amplifier

Figure 22 shows a true differential connection that has few of the problems mentioned previously. It has an input resistance greater than $10^{10}\Omega$, yet it does not need large resistors in the feedback circuitry. With the component values shown, A_1 is connected as a non-inverting amplifier with a gain of 1.01; and it feeds into A_2 which has an inverting gain of 100. Hence, the total gain from the input of A_1 to the output of A_2 is 101, which is equal to the non-inverting gain of A_2 . If all the resistors are matched, the circuit responds only to the differential input signal—not the common mode voltage.

This circuit has the same sensitivity to resistors matching as the previous circuits, with a 1 percent mismatch between two resistors lowering the common mode rejection to 80 dB. However, matching is more easily accomplished because of the lower resistor values. Further, the high frequency common mode rejection is less affected by stray capacitances. The high frequency rejection is limited, though, by the response of A_1 .

logarithmic converter

A logarithmic amplifier is another circuit that can take advantage of the low input current of an op amp to increase dynamic range. Most practical log converters make use of the logarithmic relationship between the emitter-base voltage of standard double-diffused transistors and their collector current. This logarithmic characteristic has been proven true for over 9 decades of collector current. The only problem involved in using transistors as logging elements is that the scale factor has a temperature sensitivity of 0.3 percent/ $^{\circ}\text{C}$. However, temperature compensating resistors have been developed to compensate for this characteristic, making possible log converters that are accurate over a wide temperature range.

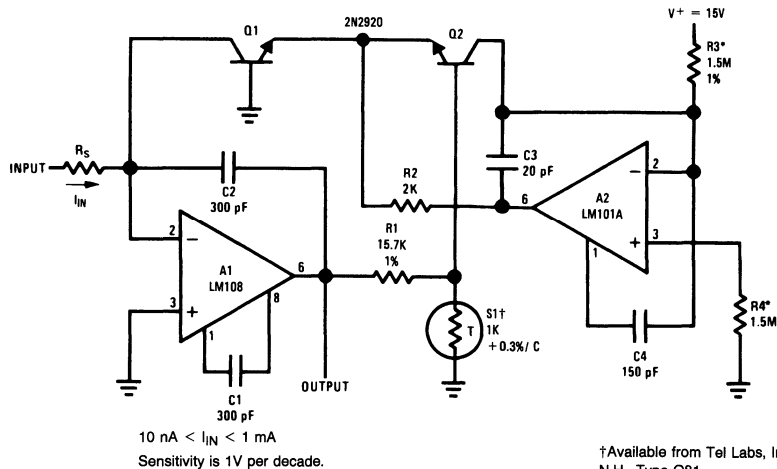


Figure 23. Temperature compensated one-quadrant logarithmic converter

Figure 23 gives a circuit that uses these techniques. Q_1 is the logging transistor, while Q_2 provides a fixed offset to temperature compensate the emitter-base turn on voltage of Q_1 . Q_2 is operated at a fixed collector current of 10 μ A by A_2 , and its emitter-base voltage is subtracted from that of Q_1 in determining the output voltage of the circuit. The collector current of Q_2 is established by R_3 and V^+ through A_2 .

The collector current of Q_1 is proportional to the input current through R_S and, therefore, proportional to the input voltage. The emitter-base voltage of Q_1 varies as the log of the input voltage. The fixed emitter-base voltage of Q_2 subtracts from the voltage on the emitter of Q_1 in determining the voltage on the top end of the temperature-compensating resistor, S_1 .

The signal on the top of S_1 will be zero when the input current is equal to the current through R_3 at any temperature. Further, this voltage will vary logarithmically for changes in input current, although the scale factor will have a temperature coefficient of $-0.3\%/^{\circ}\text{C}$. The output of the converter is essentially multiplied by the ratio of R_1 to S_1 . Since S_1 has a positive temperature coefficient of 0.3 percent/ $^{\circ}\text{C}$, it compensates for the change in scale factor with temperature.

In this circuit, an LM101A with feedforward compensation is used for A_2 since it is much faster than the LM108 used for A_1 . Since both amplifiers are cascaded in the overall feedback loop, the reduced phase shift through A_2 insures stability.

Certain things must be considered in designing this circuit. For one, the sensitivity can be changed by varying R_1 . But R_1 must be made considerably larger than the resistance of S_1 for effective temperature compensation of the scale factor. Q_1 and Q_2 should also be matched devices in the same package, and S_1 should be at the same temperature as

these transistors. Accuracy for low input currents is determined by the error caused by the bias current of A_1 . At high currents, the behavior of Q_1 and Q_2 limits accuracy. For input currents approaching 1 mA, the 2N2920 develops logging errors in excess of 1 percent. If larger input currents are anticipated, bigger transistors must be used; and R_2 should be reduced to insure that A_2 does not saturate.

transducer amplifiers

With certain transducers, accuracy depends on the choice of the circuit configuration as much as it does on the quality of the components. The amplifier for photodiode sensors, shown in Figure 24, illustrates this point. Normally, photodiodes are operated with reverse voltage across the junction. At high temperatures, the leakage currents can approach the signal current. However, photodiodes deliver a short-circuit output current, unaffected by leakage currents, which is not significantly lower than the output current with reverse bias.

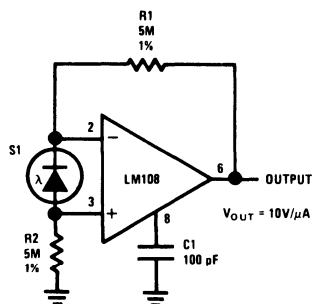
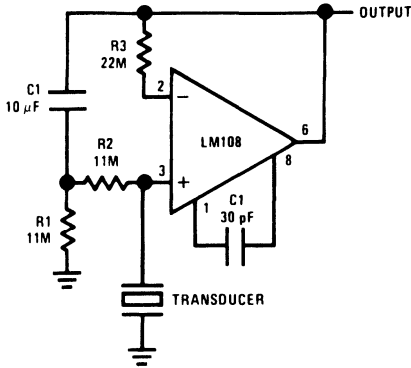


Figure 24. Amplifier for photodiode sensor



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Figure 25. Amplifier for piezoelectric transducers

The circuit shown in Figure 24 responds to the short-circuit output current of the photodiode. Since the voltage across the diode is only the offset voltage of the amplifier, inherent leakage is reduced by at least two orders of magnitude. Neglecting the offset current of the amplifier, the output current of the sensor is multiplied by R_1 plus R_2 in determining the output voltage.

Figure 25 shows an amplifier for high-impedance ac transducers like a piezoelectric accelerometer. These sensors normally require a high-input-resistance amplifier. The LM108 can provide input resistances in the range of 10 to 100 M Ω , using conventional circuitry. However, conventional designs are sometimes ruled out either because large resistors cannot be used or because prohibitively large input resistances are needed.

Using the circuit in Figure 25, input resistances that are orders of magnitude greater than the values of the dc return resistors can be obtained. This is accomplished by bootstrapping the resistors to the output. With this arrangement, the lower cutoff frequency of a capacitive transducer is determined more by the RC product of R_1 and C_1 than it is by resistor values and the equivalent capacitance of the transducer.

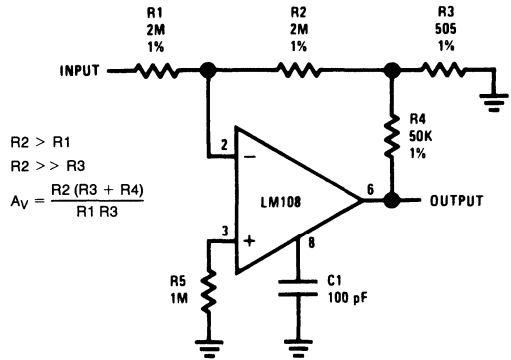
resistance multiplication

When an inverting operational amplifier must have high input resistance, the resistor values required can get out of hand. For example, if a 2 M Ω input resistance is needed for an amplifier with a gain of 100, a 200 M Ω feedback resistor is called for. This resistance can, however, be reduced using the circuit in Figure 26. A divider with a ratio of 100 to 1 (R_3 and R_4) is added to the output of the amplifier: Unity-gain feedback is applied from the output of the divider, giving an overall gain of 100 using only 2 M Ω resistors.

This circuit does increase the offset voltage somewhat. The output offset voltage is given by

$$V_{OUT} = \left(\frac{R_1 + R_2}{R_2} \right) A_V V_{OS}$$

The offset voltage is only multiplied by $A_V + 1$ in a conventional inverter. Therefore, the circuit in Figure 26 multiplies the offset by 200, instead of 101. This multiplication factor can be reduced to 110 by increasing R_2 to 20 M Ω and R_3 to 5.55k.



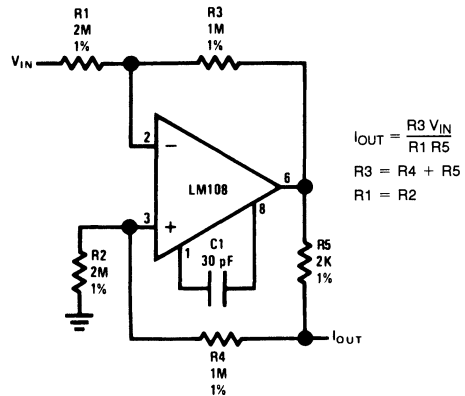
TL/H/6875-27

Figure 26. Inverting amplifier with high input resistance

Another disadvantage of the circuit is that four resistors determine the gain, instead of two. Hence, for a given resistor tolerance, the worst-case gain deviation is greater, although this is probably more than offset by the ease of getting better tolerances in the low resistor values.

current sources

Although there are numerous ways to make current sources with op amps, most have limitations as far as their application is concerned. Figure 27, however, shows a current source which is fairly flexible and has few restrictions as far as its use is concerned. It supplies a current that is proportional to the input voltage and drives a load referred to ground or any voltage within the output-swing capability of the amplifier.



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Figure 27. Bilateral current source

With the output grounded, it is relatively obvious that the output current will be determined by R_5 and the gain setting of the op amp, yielding

$$I_{OUT} = - \frac{R_3 V_{IN}}{R_1 R_5}$$

When the output is not at zero, it would seem that the current through R_2 and R_4 would reduce accuracy. Nonetheless, if $R_1 = R_2$ and $R_3 = R_4 + R_5$, the output current will

be independent of the output voltage. For $R_1 + R_3 \gg R_5$, the output resistance of the circuit is given by

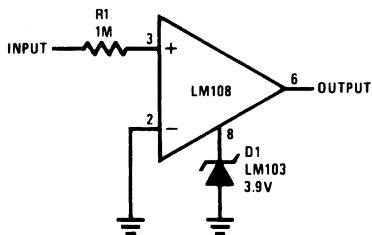
$$R_{OUT} \cong R_5 \left(\frac{R}{\Delta R} \right)$$

where R is any one of the feedback resistors (R_1, R_2, R_3 or R_4) and ΔR is the incremental change in the resistor value from design center. Hence, for the circuit in *Figure 27*, a 1 percent deviation in one of the resistor values will drop the output resistance of 200 k Ω . Such errors can be trimmed out by adjusting one of the feedback resistors. In design, it is advisable to make the feedback resistors as large as possible. Otherwise, resistor tolerances become even more critical.

The circuit must be driven from a source resistance which is low by comparison to R_1 , since this resistance will imbalance the circuit and affect both gain and output resistance. As shown, the circuit gives a negative output current for a positive input voltage. This can be reversed by grounding the input and driving the ground end of R_2 . The magnitude of the scale factor will be unchanged as long as $R_4 \gg R_5$.

voltage comparators

Like most op amps, it is possible to use the LM108 as a voltage comparator. *Figure 28* shows the device used as a simple zero-crossing detector. The inputs of the IC are pro-



TL/H/6875-29

Figure 28. Zero crossing detector

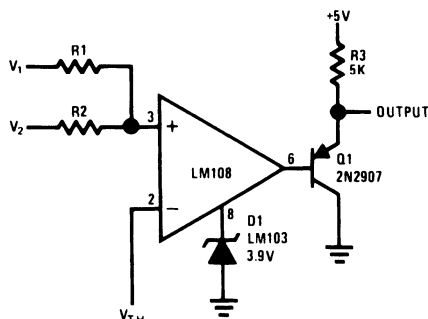
tected internally by back-to-back diodes connected between them, therefore, voltages in excess of 1V cannot be impressed directly across the inputs. This problem is taken care of by R_1 which limits the current so that input voltages in excess of 1 kV can be tolerated. If absolute accuracy is required or if R_1 is made much larger than 1 M Ω , a compensating resistor of equal value should be inserted in series with the other input.

In *Figure 28*, the output of the op amp is clamped so that it can drive DTL or TTL directly. This is accomplished with a clamp diode on pin 8. When the output swings positive, it is clamped at the breakdown voltage of the zener. When it swings negative, it is clamped at a diode drop below ground. If the 5V logic supply is used as a positive supply for the amplifier, the zener can be replaced with an ordinary silicon diode. The maximum fan out that can be handled by the device is one for standard DTL or TTL under worst case conditions.

As might be expected, the LM108 is not very fast when used as a comparator. The response time is up in the tens of microseconds. An LM103¹¹ is recommended for D_1 , rather than a conventional alloy zener, because it has lower capacitance and will not slow the circuit further. The sharp breakdown of the LM103 at low currents is also an advantage as the current through the diode in clamp is only 10 μ A.

Figure 29 shows a comparator for voltages of opposite polarity. The output changes state when the voltage on the junction of R_1 and R_2 is equal to V_{TH} . Mathematically, this is expressed by

$$V_{TH} = V_2 + \frac{R_2(V_1 - V_2)}{R_1 + R_2}$$



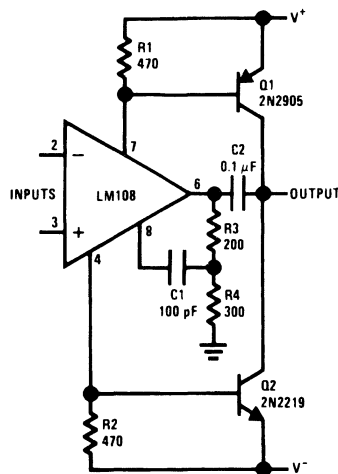
TL/H/6875-30

Figure 29. Voltage comparator with output buffer

The LM108 can also be used as a differential comparator, going through a transition when two input voltages are equal. However, resistors must be inserted in series with the inputs to limit current and minimize loading on the signal sources when the input-protection diodes conduct. *Figure 29* also shows how a PNP transistor can be added on the output to increase the fan out to about 20 with standard DTL or TTL.

power booster

The LM108, which was designed for low power consumption, is not able to drive heavy loads. However, a relatively simple booster can be added to the output to increase the output current to ± 50 mA. This circuit, shown in *Figure 30*, has the added advantage that it swings the output up to the supplies, within a fraction of a volt. The increased voltage swing is particularly helpful in low voltage circuits.



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Figure 30. Power booster

In Figure 30, the output transistors are driven from the supply leads of the op amp. It is important that R_1 and R_2 be made low enough so Q_1 and Q_2 are not turned on by the *worst case* quiescent current of the amplifier. The output of the op amp is loaded heavily to ground with R_3 and R_4 .

When the output swings about 0.5V positive, the increasing positive supply current will turn on Q_1 which pulls up the load. A similar situation occurs with Q_2 for negative output swings.

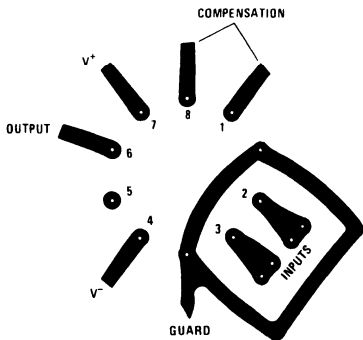
The bootstrapped shunt compensation shown in the figure is the only one that seems to work for all loading conditions. This capacitor, C_1 , can be made inversely proportional to the closed loop gain to optimize frequency response. The value given is for a unity-gain follower connection. C_2 is also required for loop stability.

The circuit does have a dead zone in the open loop transfer characteristic. However, the low frequency gain is high enough so that it can be neglected. Around 1 kHz, though, the dead zone becomes quite noticeable.

Current limiting can be incorporated into the circuit by adding resistors in series with the emitters of Q_1 and Q_2 because the short circuit protection of the LM108 limits the maximum voltage drop across R_1 and R_2 .

board construction

As indicated previously, certain precautions must be observed when building circuits that are sensitive to very low currents. If proper care is not taken, board leakage currents can easily become much larger than the error currents of the op amp. To prevent this, it is necessary to thoroughly clean printed circuit boards. Even experimental breadboards must be cleaned with trichloroethylene or alcohol to remove solder fluxes, and blown dry with compressed air. These fluxes may be insulators at low impedance levels—like in electric motors—but they certainly are not in high impedance circuits. In addition to causing gross errors, their presence can make the circuit behave erratically, especially as the temperature is changed.



Bottom View

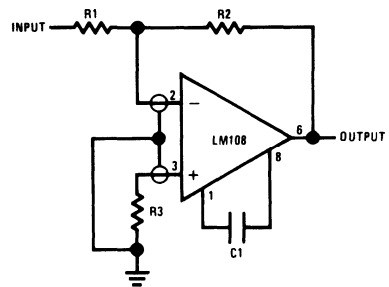
Figure 31. Printed circuit layout for input guarding with TO-5 package

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At elevated temperatures, even the leakage of clean boards can be a headache. At 125°C the leakage resistance between adjacent runs on a printed circuit board is about $10^{11}\Omega$ (0.05-inch separation parallel for 1 inch) for high quality epoxy-glass boards that have been properly cleaned. Therefore, the boards can easily produce error currents in the order of 200 pA and much more if they become contaminated. Conservative practice dictates that the boards be coated with epoxy or silicone rubber after cleaning to prevent contamination. Silicone rubber is the easiest to use. However, if the better durability of epoxy is needed, care must be taken to make sure that it gets thoroughly cured. Otherwise, the epoxy will make high temperature leakage much worse.

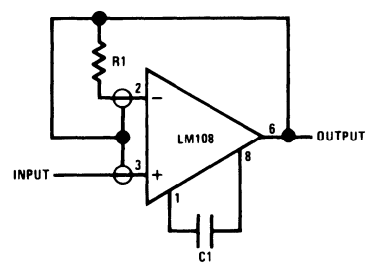
Care must also be exercised to insure that the circuit board is protected from condensed water vapor when operating in the vicinity of 0°C. This can usually be accomplished by coating the board as mentioned above.

a. inverting amplifier



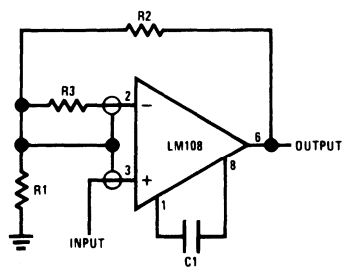
TL/H/6875-33

b. follower



TL/H/6875-34

c. non-inverting amplifier



TL/H/6875-35

Figure 32. Connection of input guards

guarding

Even with properly cleaned and coated boards, leakage currents are on the verge of causing trouble at 125°C. The standard pin configuration of most IC op amps has the input pins adjacent to pins which are at the supply potentials. Therefore, it is advisable to employ guarding to reduce the voltage difference between the inputs and adjacent metal runs.

A board layout that includes input guarding is shown in *Figure 31* for the eight lead TO-5 package. A ten-lead pin circle is used, and the leads of the IC are formed so that the holes adjacent to the inputs are vacant when it is inserted in the board. The guard, which is a conductive ring surrounding the inputs, is then connected to a low impedance point that is at the same potential as the inputs. The leakage currents from the pins at the supply potentials are absorbed by the guard. The voltage difference between the guard and the inputs can be made approximately equal to the offset voltage, reducing the effective leakage by more than three orders of magnitude. If the leads of the integrated circuit, or other components connected to the input, go through the board, it may be necessary to guard both sides.

Figure 32 shows how the guard is committed on the more-common op amp circuits. With an integrator or inverting amplifier, where the inputs are close to ground potential, the guard is simply grounded. With the voltage follower, the guard is bootstrapped to the output. If it is desirable to put a resistor in the inverting input to compensate for the source resistance, it is connected as shown in *Figure 32b*.

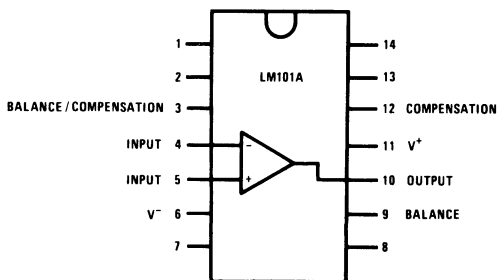
Guarding a non-inverting amplifier is a little more complicated. A low impedance point must be created by using relatively low value feedback resistors to determine the gain (R_1 and R_2 in *Figure 32c*). The guard is then connected to the junction of the feedback resistors. A resistor, R_3 , can be connected as shown in the figure to compensate for large source resistances.

With the dual-in-line and flat packages, it is far more difficult to guard the inputs, if the standard pin configuration of the LM709 or LM101A is used, because the pin spacings on these packages are fixed. Therefore, the pin configuration of the LM108 was changed, as shown in *Figure 33*.

conclusions

IC op amps are now available that equal the input current specifications of FET amplifiers in all but the most restricted temperature range applications. At operating temperatures above 85°C, the IC is clearly superior as it uses bipolar transistors that make it possible to eliminate the leakage currents that plague FETs. Additionally, bipolar transistors match better than FETs, so low offset voltage and drifts can be obtained without expensive adjustments or selection. Further, the bipolar devices lend themselves more readily to low-cost monolithic construction.

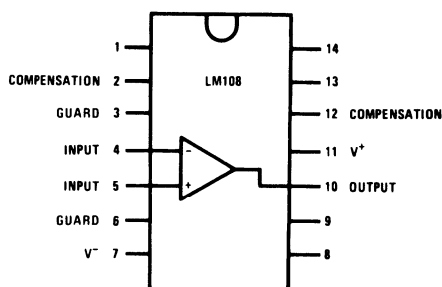
These amplifiers open up new application areas and vastly improve performance in others. For example, in analog memories, holding intervals can be extended to minutes, even where -55°C to 125°C operation is involved. Instrumentation amplifiers and low frequency waveform generators also benefit from the low error currents.



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NOTE: Pin 6 connected to bottom of package.

Top View



TL/H/6875-39

NOTE: Pin 7 connected to bottom of package

Top View

Figure 33. Comparing connection diagrams of the LM101A and LM108, showing addition of guarding

When operating above 85°C, overall performance is frequently limited by components other than the op amp, unless certain precautions are observed. It is generally necessary to redesign circuits using semiconductor switches to reduce the effect of their leakage currents. Further, high quality capacitors must be used, and care must be exercised in selecting large value resistors. Printed circuit board leakages can also be troublesome unless the boards are properly treated. And above 100°C, it is almost mandatory to employ guarding on the boards to protect the inputs, if the full potential of the amplifier is to be realized.

appendix

A complete schematic of the LM108 is given in *Figure A1*. A description of the basic circuit is presented along with a simplified schematic earlier in the text. The purpose of this Appendix is to explain some of the more subtle features of the design.

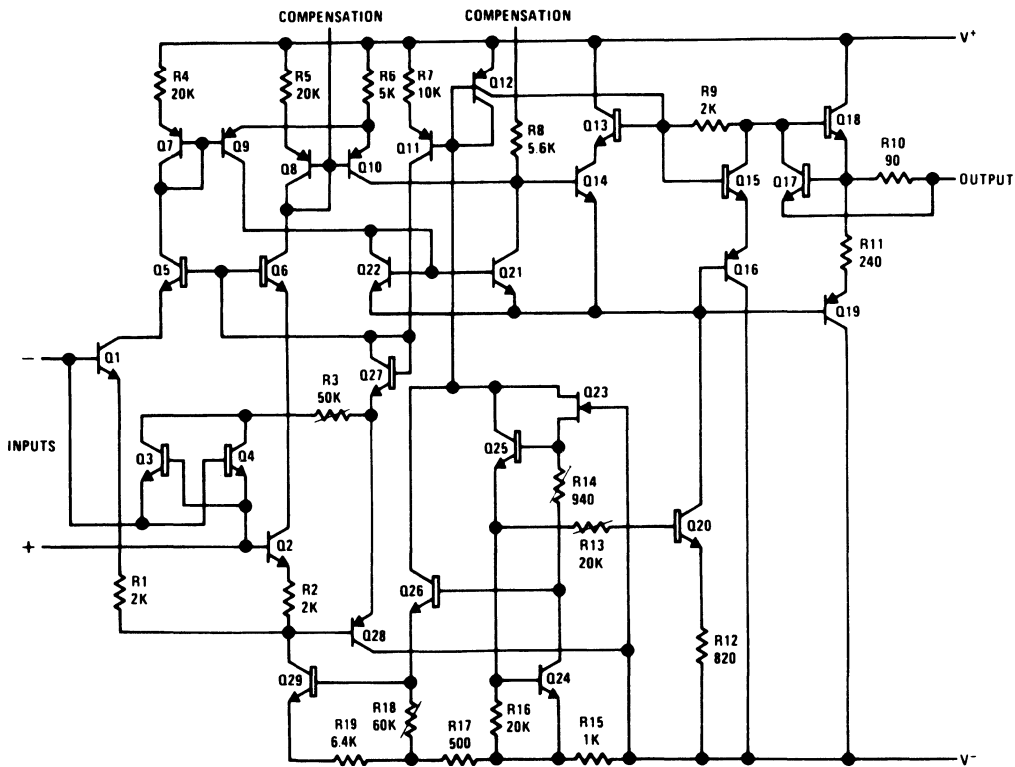
The current source supplying the input transistors is Q_{29} . It is designed to supply a total input stage current of $6 \mu\text{A}$ at 25°C. This current drops to $3 \mu\text{A}$ at -55°C but increases to only $7.5 \mu\text{A}$ at 125°C . This temperature characteristic tends

to compensate for the current gain falloff of the input transistors at low temperatures without creating stability problems at high temperatures.

The biasing circuitry for the input current source is nearly identical to that in the LM101A, and a complete description is given in Reference 4. However, a brief explanation follows.

A collector FET,⁶ Q_{23} , which has a saturation current of about $30 \mu\text{A}$, establishes the collector current of Q_{24} . This FET provides the initial turn-on current for the circuit and insures starting under all conditions. The purpose of R_{14} is to compensate for production and temperature variations in the FET current. It is a collector resistor (indicated by the T through it) made of the same semiconductor material as the FET channel. As the FET current varies, the drop across R_{14} tends to compensate for changes in the emitter base voltage of Q_{24} .

The collector-emitter voltage of Q_{24} is equal to the emitter base voltage of Q_{24} plus that of Q_{25} . This voltage is delivered to Q_{26} and Q_{29} . Q_{25} and Q_{24} are operated at substantially higher currents than Q_{26} and Q_{29} . Hence, there is a



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Figure A1. Complete schematic of the LM108

differential in their emitter base voltages that is dropped across R_{19} to determine the input stage current. R_{18} is a pinched base resistor, as is indicated by the slash bar through it. This resistor, which has a large positive temperature coefficient, operates in conjunction with R_{17} to help shape the temperature characteristics of the input stage current source.

The output currents of Q_{26} , Q_{25} , and Q_{23} are fed to Q_{12} , which is a controlled-gain lateral PNP.⁶ It delivers one-half of the combined currents to the output stage. Q_{11} is also connected to Q_{12} , with its output current set at approximately 15 μ A by R_7 . Since this type of current source makes use of the emitter-base voltage differential between similar transistors operating at different collector currents, the output of Q_{11} is relatively independent of the current delivered to Q_{12} .¹² This current is used for the input stage bootstrapping circuitry.

Q_{20} also supplies current to the class-B output stage. Its output current is determined by the ratio of R_{15} to R_{12} and the current through R_{12} . R_{13} is included so that the biasing circuit is not upset when Q_{20} saturates.

One major departure from the simplified schematic is the bootstrapping of the second stage active loads, Q_{21} and Q_{22} , to the output. This makes the second stage gain dependent only on how well Q_9 and Q_{10} match with variations in output voltage. Hence, the second stage gain is quite high. In fact, the overall gain of the amplifier is typically in excess of 10^6 at dc.

The second stage active loads drive Q_{14} . A high-gain primary transistor is used to prevent loading of the second stage. Its collector is bootstrapped by Q_{13} to operate it at zero collector-base voltage. The class-B output stage is actually driven by the emitter of Q_{14} .

A dead zone in the output stage is prevented by biasing Q_{18} and Q_{19} on the verge of conduction with Q_{15} and Q_{16} . R_9 is used to compensate for the transconductance of Q_{15} and Q_{16} , making the output stage quiescent current relatively independent of the output current of Q_{12} . The drop across this resistor also reduces quiescent current.

For positive-going outputs, short circuit protection is provided by R_{10} and Q_{17} . When the voltage drop across R_{10} turns on Q_{17} , it removes base drive from Q_{18} . For negative-going outputs, current limiting is initiated when the voltage drop across R_{11} becomes large enough for the collector base junction of Q_{17} to become forward biased. When this happens, the base of Q_{19} is clamped so the output current cannot increase further.

Input protection is provided by Q_3 and Q_4 which act as clamp diodes between the inputs. The collectors of these transistors are bootstrapped to the emitter of Q_{28} through R_3 . This keeps the collector-isolation leakage of the transistors from showing up on the inputs. R_3 is included so that the bootstrapping is not disrupted when Q_3 or Q_4 saturate with an input overload. Current-limiting resistors were not connected in series with the inputs, since diffused resistors cannot be employed such that they work effectively, without causing high temperature leakages.

TABLE I. Typical Performance of the LM108 Operational Amplifier ($T_A = 25^\circ\text{C}$ and $V_S = \pm 15\text{V}$)

Input Offset Voltage	0.7 mV
Input Offset Current	50 pA
Input Bias Current	0.8 nA
Input Resistance	70 M Ω
Input Common Mode Range	$\pm 14\text{V}$
Common Mode Rejection	100 dB
Offset Voltage Drift	3 $\mu\text{V}/^\circ\text{C}$
Offset Current Drift	0.5 pA/ $^\circ\text{C}$
Voltage Gain	300V/mW
Small Signal Bandwidth	1.0 MHz
Slew Rate	0.3V/ μs
Output Swing	$\pm 14\text{V}$
Supply Current	300 μA
Power Supply Rejection	100 dB
Operating Voltage Range	$\pm 2\text{V}$ to $\pm 20\text{V}$

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Log Converters

National Semiconductor
Application Note 30



One of the most predictable non-linear elements commonly available is the bipolar transistor. The relationship between collector current and emitter base voltage is precisely logarithmic from currents below one picoamp to currents above one milliamp. Using a matched pair of transistors and integrated circuit operational amplifiers, it is relatively easy to construct a linear to logarithmic converter with a dynamic range in excess of five decades.

The circuit in *Figure 1* generates a logarithmic output voltage for a linear input current. Transistor Q_1 is used as the non-linear feedback element around an LM108 operational amplifier. Negative feedback is applied to the emitter of Q_1 through divider, R_1 and R_2 , and the emitter base junction of Q_2 . This forces the collector current of Q_1 to be exactly equal to the current through the input resistor. Transistor Q_2 is used as the feedback element of an LM101A operational amplifier. Negative feedback forces the collector current of Q_2 to equal the current through R_3 . For the values shown, this current is 10 μ A. Since the collector current of Q_2 remains constant, the emitter base voltage also remains constant. Therefore, only the V_{BE} of Q_1 varies with a change of input current. However, the output voltage is a function of the difference in emitter base voltages of Q_1 and Q_2 :

$$E_{OUT} = \frac{R_1 + R_2}{R_2} (V_{BE2} - V_{BE1}). \quad (1)$$

For matched transistors operating at different collector currents, the emitter base differential is given by

$$\Delta V_{BE} = \frac{kT}{q} \log_e \frac{I_{C1}}{I_{C2}}, \quad (2)$$

where k is Boltzmann's constant, T is temperature in degrees Kelvin and q is the charge of an electron. Combining these two equations and writing the expression for the output voltage gives

$$E_{OUT} = \frac{-kT}{q} \left[\frac{R_1 + R_2}{R_2} \right] \log_e \left[\frac{E_{IN} R_3}{E_{REF} R_{IN}} \right] \quad (3)$$

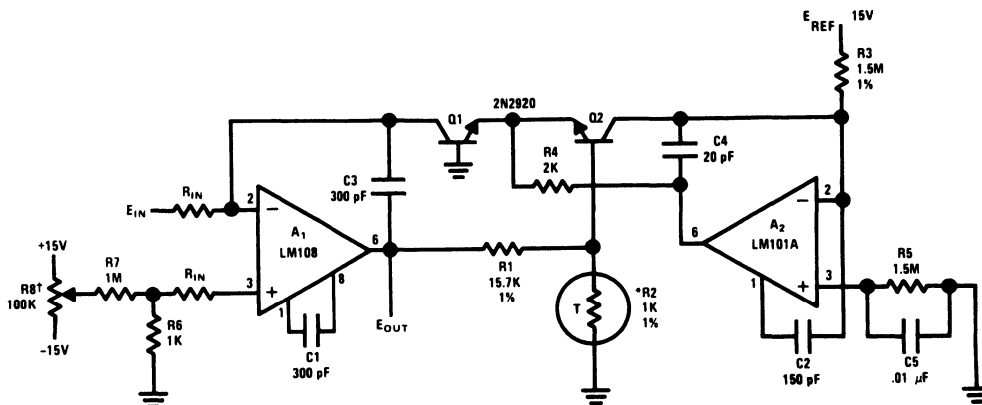
for $E_{IN} \geq 0$. This shows that the output is proportional to the logarithm of the input voltage. The coefficient of the log term is directly proportional to absolute temperature. Without compensation, the scale factor will also vary directly with temperature. However, by making R_2 directly proportional to temperature, constant gain is obtained. The temperature compensation is typically 1% over a temperature range of -25°C to 100°C for the resistor specified. For limited temperature range applications, such as 0°C to 50°C , a 430Ω sensistor in series with a 570Ω resistor may be substituted for the $1k$ resistor, also with 1% accuracy. The divider, R_1 and R_2 , sets the gain while the current through R_3 sets the zero. With the values given, the scale factor is $1V/\text{decade}$ and

$$E_{OUT} = - \left[\log_{10} \left| \frac{E_{IN}}{R_{IN}} \right| + 5 \right] \quad (4)$$

where the absolute value sign indicates that the dimensions of the quantity inside are to be ignored.

Log generator circuits are not limited to inverting operation. In fact, a feature of this circuit is the ease with which non-inverting operation is obtained. Supplying the input signal to A_2 and the reference current to A_1 results in a log output that is not inverted from the input. To achieve the same 100 dB dynamic range in the non-inverting configuration, an LM108 should be used for A_2 , and an LM101A for A_1 . Since the LM108 cannot use feedforward compensation, it is frequency compensated with the standard 30 pF capacitor.

The only other change is the addition of a clamp diode connected from the emitter of Q_1 to ground. This prevents damage to the logging transistors if the input signal should go negative.



*Tel Labs Type Q_{B1} Manchester, N.H.

†Offset Voltage Adjust

FIGURE 1. Log Generator with 100 dB Dynamic Range

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The log output is accurate to 1% for any current between 10 nA and 1 mA. This is equivalent to about 3% referred to the input. At currents over 500 μ A the transistors used deviate from log characteristics due to resistance in the emitter, while at low currents, the offset current of the LM108 is the major source of error. These errors occur at the ends of the dynamic range, and from 40 nA to 400 μ A the log converter is 1% accurate referred to the input. Both of the transistors are used in the grounded base connection, rather than the diode connection, to eliminate errors due to base current. Unfortunately, the grounded base connection increases the loop gain. More frequency compensation is necessary to prevent oscillation, and the log converter is necessarily slow. It may take 1 to 5 ms for the output to settle to 1% of its final value. This is especially true at low currents.

The circuit shown in Figure 2 is two orders of magnitude faster than the previous circuit and has a dynamic range of 80 dB. Operation is the same as the circuit in Figure 1, except the configuration optimizes speed rather than dynamic range. Transistor Q₁ is diode connected to allow the use of feedforward compensation¹ on an LM101A operational amplifier. This compensation extends the bandwidth to 10 MHz and increases the slew rate. To prevent errors due to the finite h_{FE} of Q₁ and the bias current of the LM101A, an LM102 voltage follower buffers the base current and input current. Although the log circuit will operate without the LM102, accuracy will degrade at low input currents. Amplifier A₂ is also compensated for maximum bandwidth. As with the previous log converter, R₁ and R₂ control the sensitivity; and R₃ controls the zero crossing of the transfer function. With the values shown the scale factor is 1V/decade and

$$E_{OUT} = - \left[\log_{10} \left| \frac{E_{IN}}{R_{IN}} \right| + 4 \right] \quad (5)$$

from less than 100 nA to 1 mA.

Anti-log or exponential generation is simply a matter of rearranging the circuitry. Figure 3 shows the circuitry of the log converter connected to generate an exponential output from a linear input. Amplifier A₁ in conjunction with transistor Q₁ drives the emitter of Q₂ in proportion to the input voltage. The collector current of Q₂ varies exponentially with the emitter-base voltage. This current is converted to a voltage by amplifier A₂. With the values given

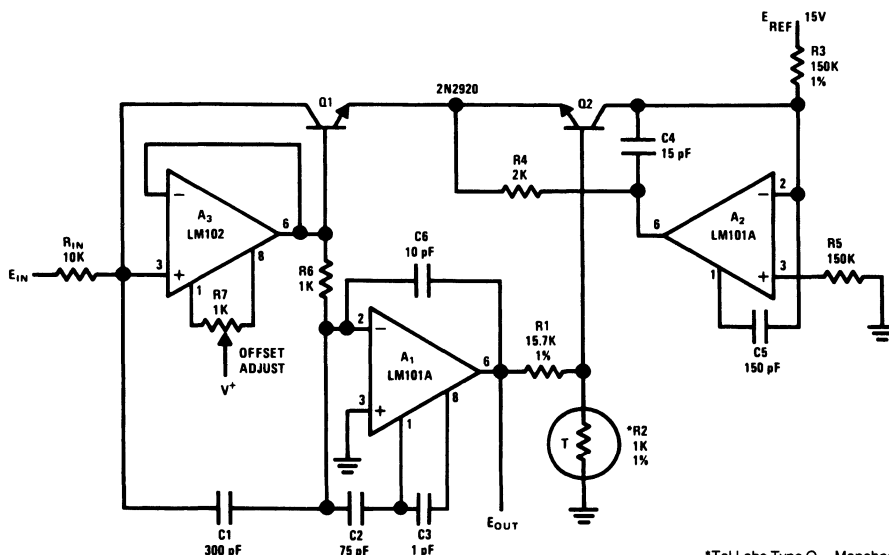
$$E_{OUT} = 10^{-[E_{IN}]} \quad (6)$$

Many non-linear functions such as $X^{1/2}$, X^2 , X^3 , $1/X$, XY , and X/Y are easily generated with the use of logs. Multiplication becomes addition, division becomes subtraction and powers become gain coefficients of log terms. Figure 4 shows a circuit whose output is the cube of the input. Actually, any power function is available from this circuit by changing the values of R₉ and R₁₀ in accordance with the expression:

$$E_{OUT} = E_{IN} \frac{16.7 R_9}{R_9 + R_{10}} \quad (7)$$

Note that when log and anti-log circuits are used to perform an operation with a linear output, no temperature compensating resistors at all are needed. If the log and anti-log transistors are at the same temperature, gain changes with temperature cancel. It is a good idea to use a heat sink which couples the two transistors to minimize thermal gradients. A 1°C temperature difference between the log and anti-log transistors results in a 0.3% error. Also, in the log converters, a 1°C difference between the log transistors and the compensating resistor results in a 0.3% error.

Either of the circuits in Figures 1 or 2 may be used as dividers or reciprocal generators. Equation 3 shows the outputs of the log generators are actually the ratio of two currents:



*Tel Labs Type Q₈₁ Manchester, N.H.

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FIGURE 2. Fast Log Generator

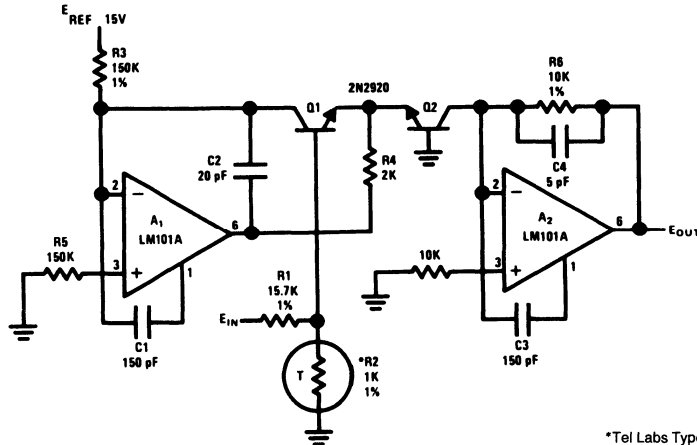
the input current and the current through R_3 . When used as a log generator, the current through R_3 was held constant by connecting R_3 to a fixed voltage. Hence, the output was just the log of the input. If R_3 is driven by an input voltage, rather than the 15V reference, the output of the log generator is the log ratio of the input current to the current through R_3 . The anti-log of this voltage is the quotient. Of course, if the divisor is constant, the output is the reciprocal.

A complete one quadrant multiplier/divider is shown in *Figure 5*. It is basically the log generator shown in *Figure 1* driving the anti-log generator shown in *Figure 3*. The log generator output from A_1 drives the base of Q_3 with a voltage proportional to the log of E_1/E_2 . Transistor Q_3 adds a voltage proportional to the log of E_3 and drives the anti-log transistor, Q_4 . The collector current of Q_4 is converted to an

output voltage by A_4 and R_7 , with the scale factor set by R_7 at $E_1 E_3/10E_2$.

Measurement of transistor current gains over a wide range of operating currents is an application particularly suited to log multiplier/dividers. Using the circuit in *Figure 5*, PNP current gains can be measured at currents from $0.4 \mu\text{A}$ to 1 mA. The collector current is the input signal to A_1 , the base current is the input signal to A_2 , and a fixed voltage to R_5 sets the scale factor. Since A_2 holds the base at ground, a single resistor from the emitter to the positive supply is all that is needed to establish the operating current. The output is proportional to collector current divided by base current, or h_{FE} .

In addition to their application in performing functional operations, log generators can provide a significant increase in



*Tel Labs Type Q₀₁ Manchester, N.H.
TL/H/7275-3

FIGURE 3. Anti-Log Generator

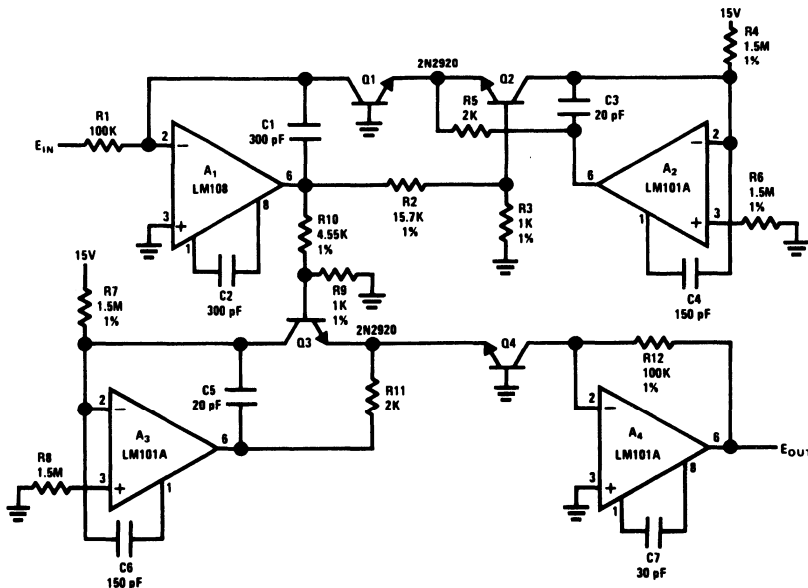


FIGURE 4. Cube Generator

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the dynamic range of signal processing systems. Also, unlike a linear system, there is no loss in accuracy or resolution when the input signal is small compared to full scale. Over most of the dynamic range, the accuracy is a percent-of-signal rather than a percent-of-full-scale. For example, using log generators, a simple meter can display signals with 100 dB dynamic range or an oscilloscope can display a 10 mV and 10V pulse simultaneously. Obviously, without the log generator, the low level signals are completely lost.

To achieve wide dynamic range with high accuracy, the input operational amplifier necessarily must have low offset voltage, bias current and offset current. The LM108 has a maximum bias current of 3 nA and offset current of 400 pA over a -55°C to 125°C temperature range. By using equal source resistors, only the offset current of the LM108 causes an error. The offset current of the LM108 is as low as many FET amplifiers. Further, it has a low and constant temperature coefficient rather than doubling every 10°C . This results in greater accuracy over temperature than can be achieved with FET amplifiers. The offset voltage may be

zeroed, if necessary, to improve accuracy with low input voltages.

The log converters are low level circuits and some care should be taken during construction. The input leads should be as short as possible and the input circuitry guarded against leakage currents. Solder residues can easily conduct leakage currents, therefore circuit boards should be cleaned before use. High quality glass or mica capacitors should be used on the inputs to minimize leakage currents. Also, when the $+15\text{V}$ supply is used as a reference, it must be well regulated.

REFERENCES

1. R. C. Dobkin, "Feedforward Compensation Speeds Op Amp", National Semiconductor Corporation, Linear Brief 2, April, 1969.
2. R. J. Widlar, "Monolithic Operational Amplifiers—The Universal Linear Component", National Semiconductor Corporation, AN-4, April, 1968.

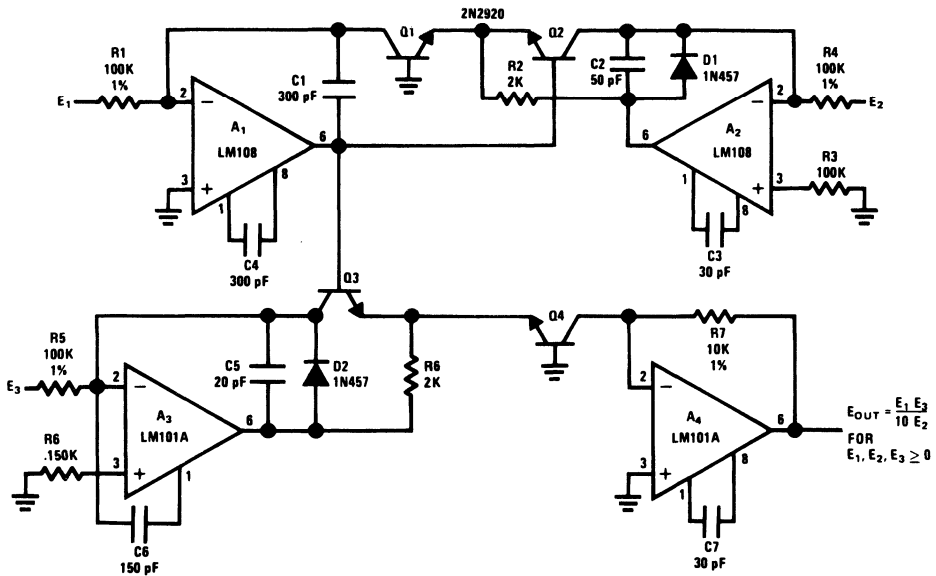


FIGURE 5. Multiplier/Divider

TL/H/7275-5

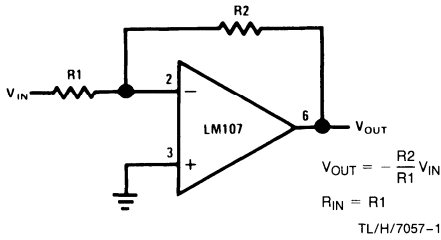
Op Amp Circuit Collection

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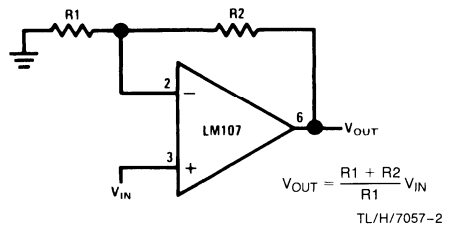


SECTION 1—BASIC CIRCUITS

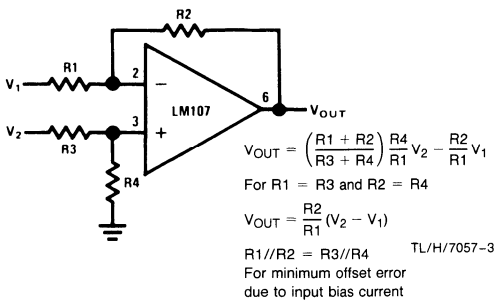
Inverting Amplifier



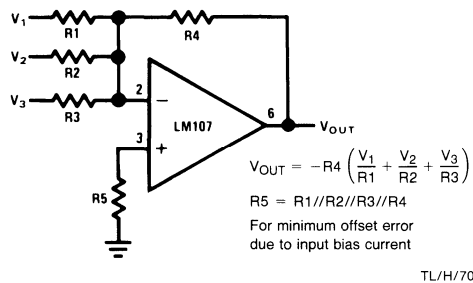
Non-Inverting Amplifier



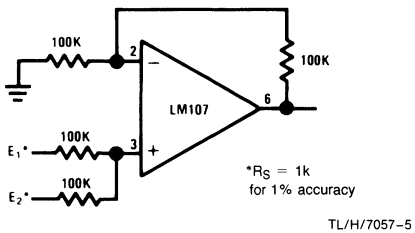
Difference Amplifier



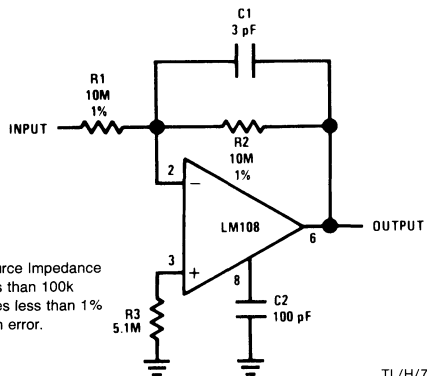
Inverting Summing Amplifier



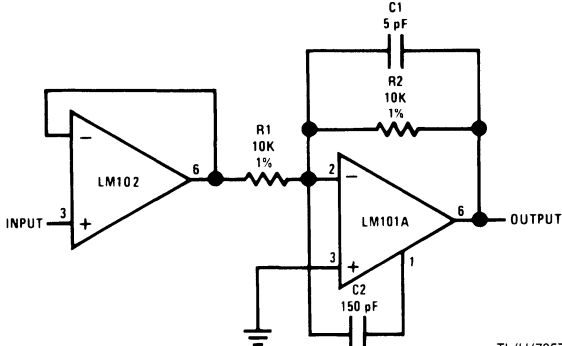
Non-Inverting Summing Amplifier



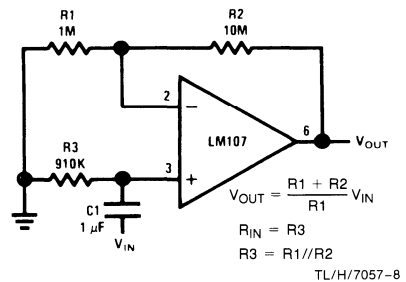
Inverting Amplifier with High Input Impedance



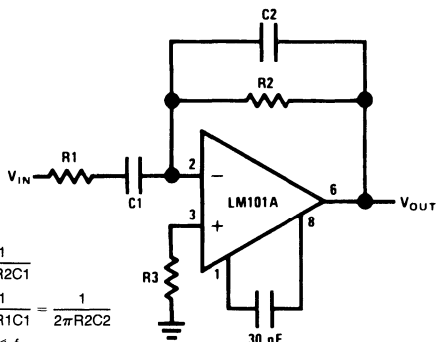
Fast Inverting Amplifier with High Input Impedance



Non-Inverting AC Amplifier



Practical Differentiator



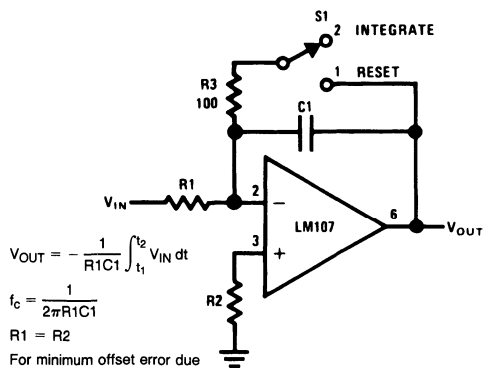
$$f_c = \frac{1}{2\pi R_2 C_1}$$

$$f_h = \frac{1}{2\pi R_1 C_1} = \frac{1}{2\pi R_2 C_2}$$

$$f_c < f_h < \text{unity gain}$$

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Integrator



$$V_{OUT} = -\frac{1}{R_1 C_1} \int_{t_1}^{t_2} V_{IN} dt$$

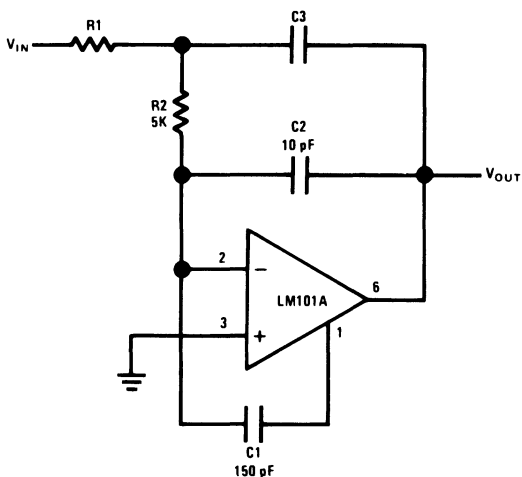
$$f_c = \frac{1}{2\pi R_1 C_1}$$

$$R_1 = R_2$$

For minimum offset error due to input bias current

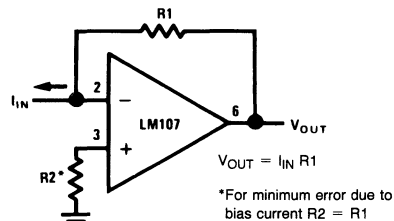
TL/H/7057-10

Fast Integrator



TL/H/7057-11

Current to Voltage Converter

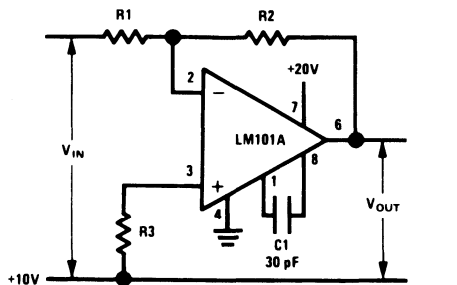


$$V_{OUT} = I_{IN} R_1$$

*For minimum error due to bias current $R_2 = R_1$

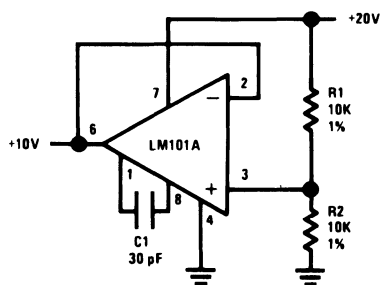
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Circuit for Operating the LM101 without a Negative Supply



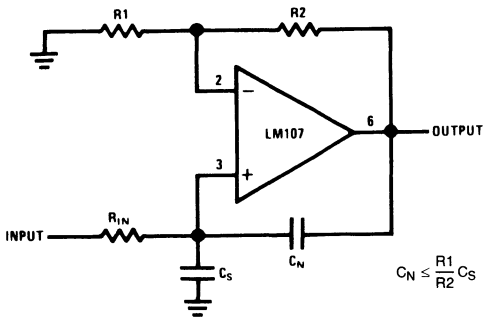
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Circuit for Generating the Second Positive Voltage



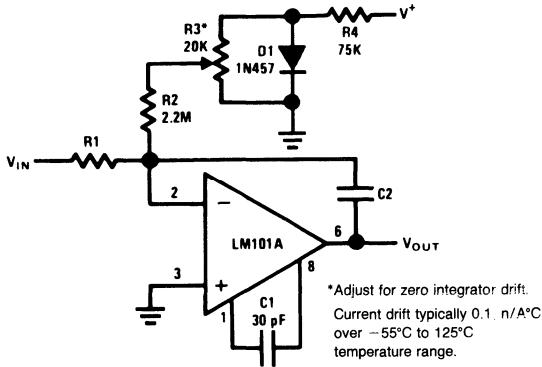
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Neutralizing Input Capacitance to Optimize Response Time



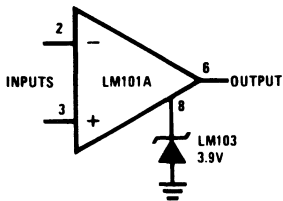
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Integrator with Bias Current Compensation



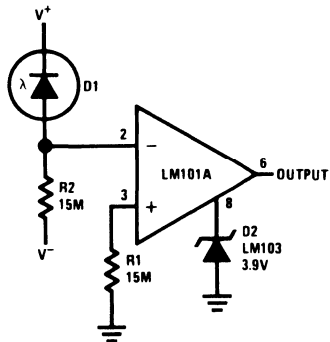
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Voltage Comparator for Driving DTL or TTL Integrated Circuits



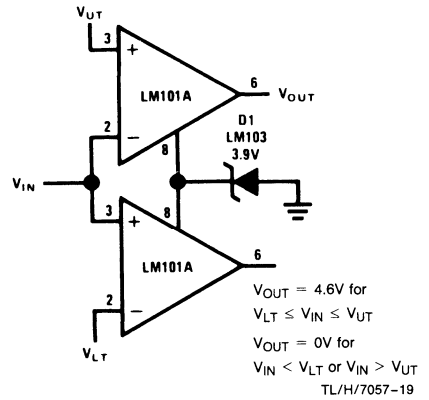
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Threshold Detector for Photodiodes



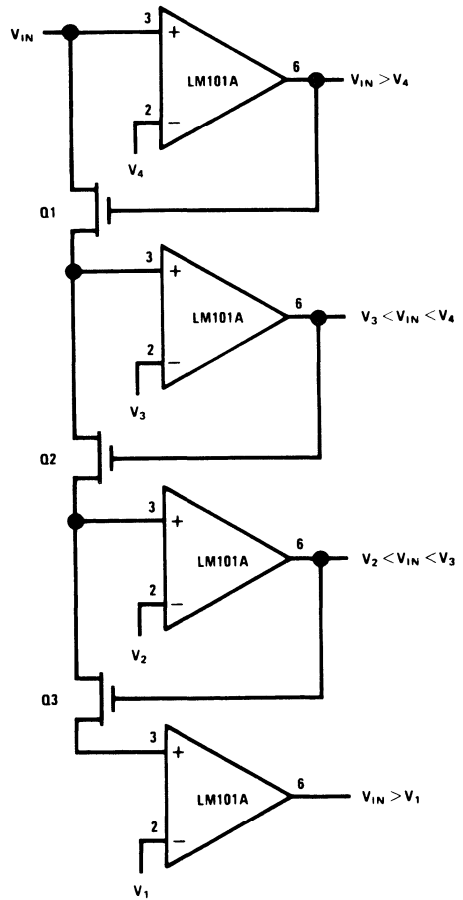
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Double-Ended Limit Detector



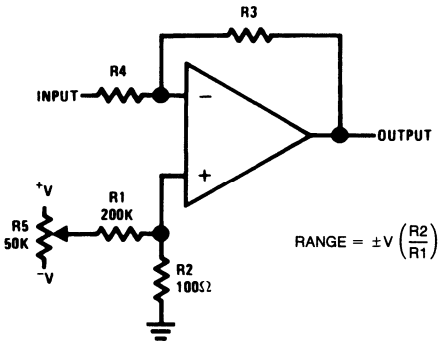
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Multiple Aperture Window Discriminator



TL/H/7057-20

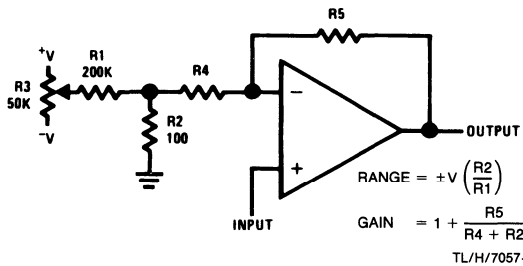
Offset Voltage Adjustment for Inverting Amplifiers Using Any Type of Feedback Element



$$\text{RANGE} = \pm V \left(\frac{R2}{R1} \right)$$

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Offset Voltage Adjustment for Inverting Amplifiers Using Any Type of Feedback Element

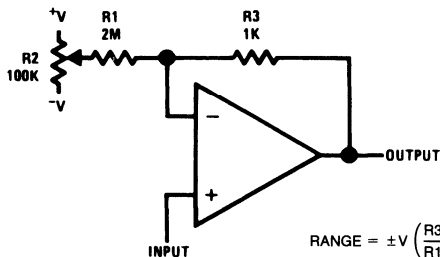


$$\text{RANGE} = +V \left(\frac{R2}{R1} \right)$$

$$\text{GAIN} = 1 + \frac{R5}{R4 + R2}$$

TL/H/7057-22

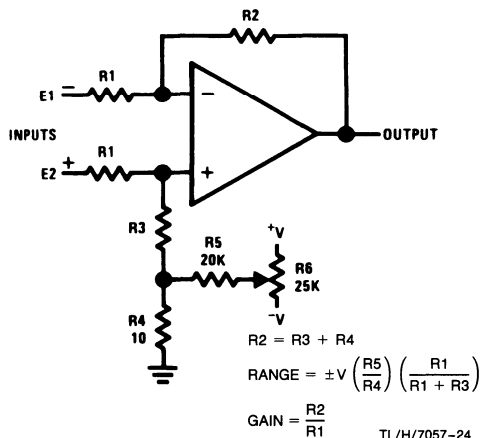
Offset Voltage Adjustment for Voltage Followers



$$\text{RANGE} = \pm V \left(\frac{R3}{R1} \right)$$

TL/H/7057-23

Offset Voltage Adjustment for Differential Amplifiers



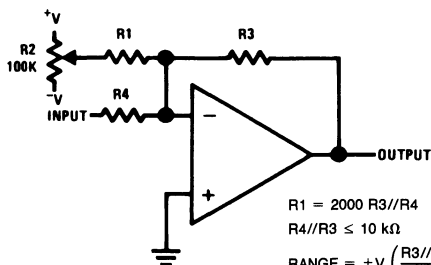
$$R2 = R3 + R4$$

$$\text{RANGE} = \pm V \left(\frac{R5}{R4} \right) \left(\frac{R1}{R1 + R3} \right)$$

$$\text{GAIN} = \frac{R2}{R1}$$

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Offset Voltage Adjustment for Inverting Amplifiers Using 10 kΩ Source Resistance or Less



$$R1 = 2000 R3 // R4$$

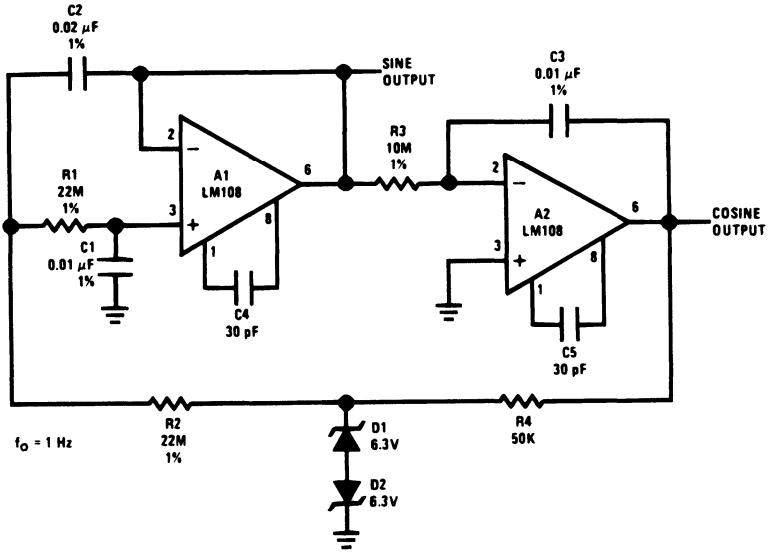
$$R4 // R3 \leq 10 \text{ k}\Omega$$

$$\text{RANGE} = +V \left(\frac{R3 // R4}{R1} \right)$$

TL/H/7057-25

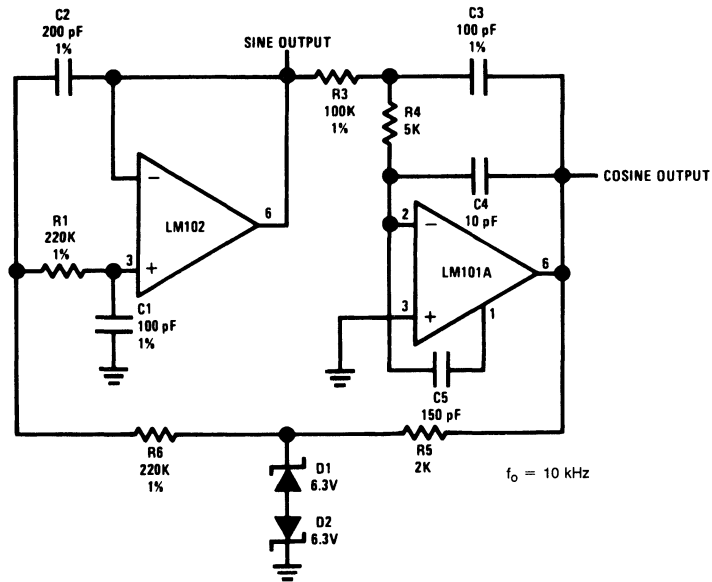
SECTION 2 — SIGNAL GENERATION

Low Frequency Sine Wave Generator with Quadrature Output



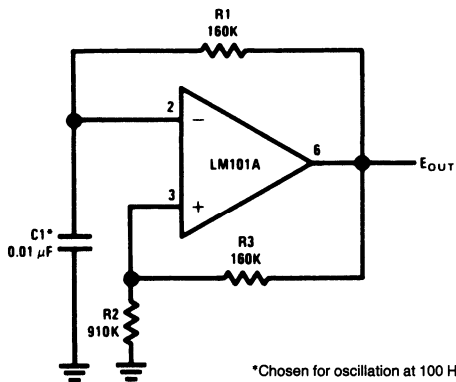
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High Frequency Sine Wave Generator with Quadrature Output



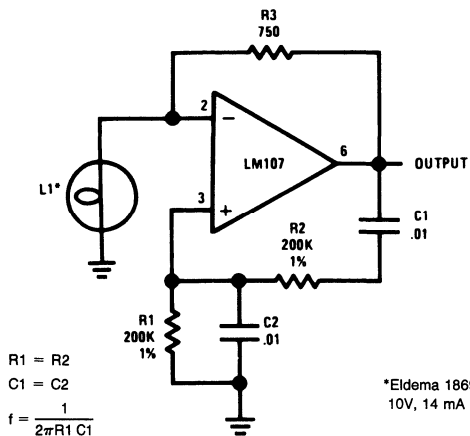
TL/H/7057-27

Free-Running Multivibrator



*Chosen for oscillation at 100 Hz
TL/H/7057-28

Wein Bridge Sine Wave Oscillator

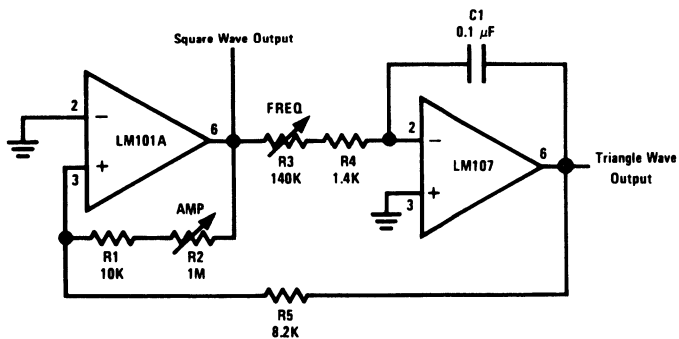


$R1 = R2$
 $C1 = C2$
 $f = \frac{1}{2\pi R1 C1}$

*Eidema 1869
10V, 14 mA Bulb

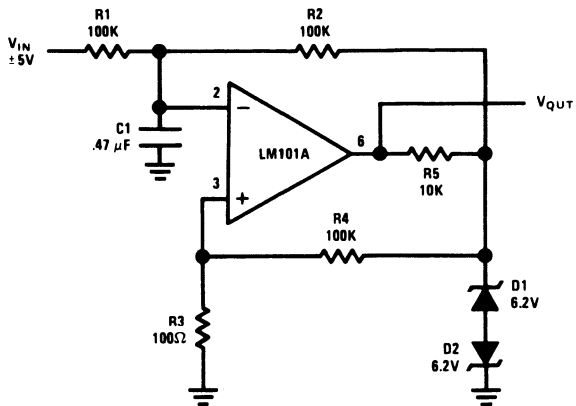
TL/H/7057-29

Function Generator



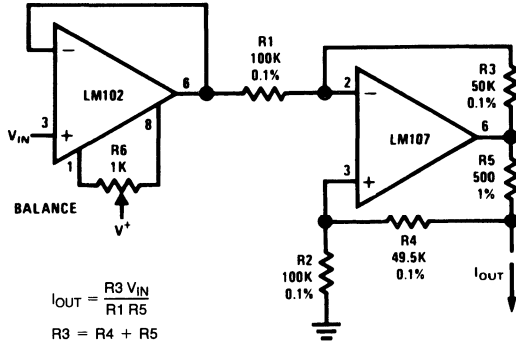
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Pulse Width Modulator



TL/H/7057-31

Bilateral Current Source



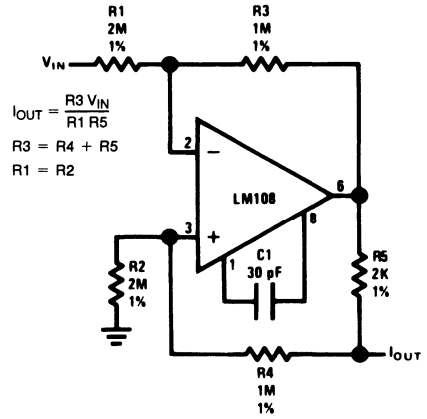
$$I_{OUT} = \frac{R_3 V_{IN}}{R_1 R_5}$$

$$R_3 = R_4 + R_5$$

$$R_1 = R_2$$

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Bilateral Current Source



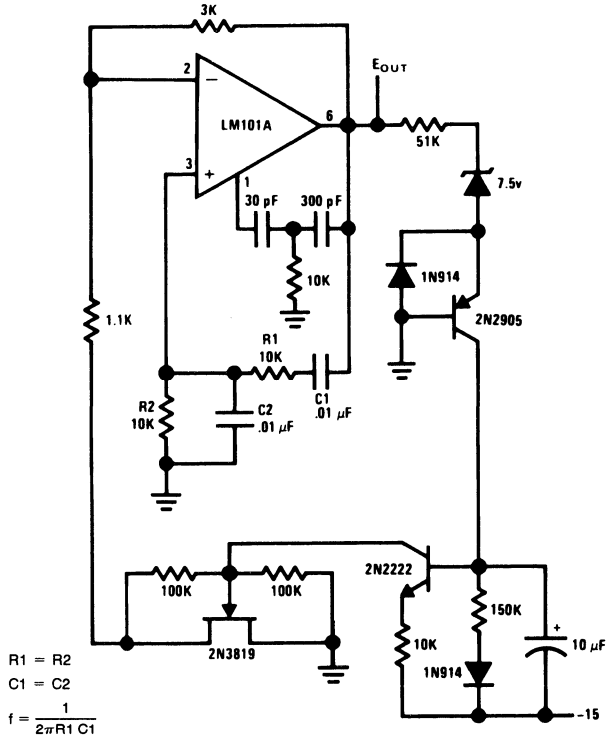
$$I_{OUT} = \frac{R_3 V_{IN}}{R_1 R_5}$$

$$R_3 = R_4 + R_5$$

$$R_1 = R_2$$

TL/H/7057-33

Wein Bridge Oscillator with FET Amplitude Stabilization



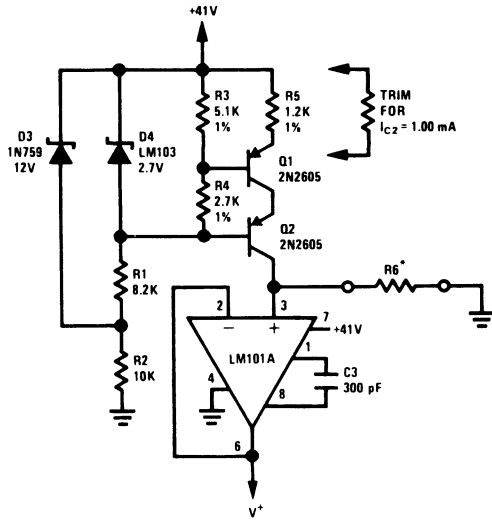
$$R_1 = R_2$$

$$C_1 = C_2$$

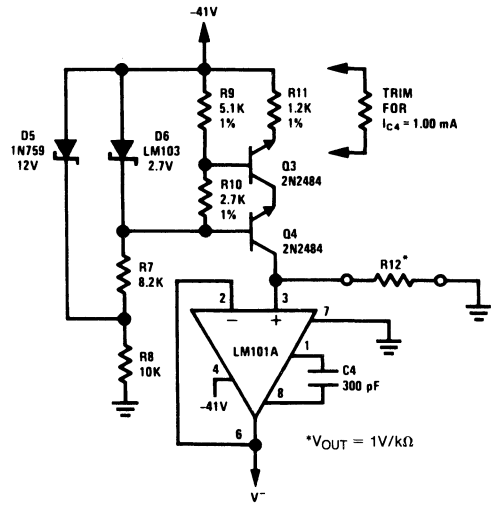
$$f = \frac{1}{2\pi R_1 C_1}$$

TL/H/7057-34

Low Power Supply for Integrated Circuit Testing

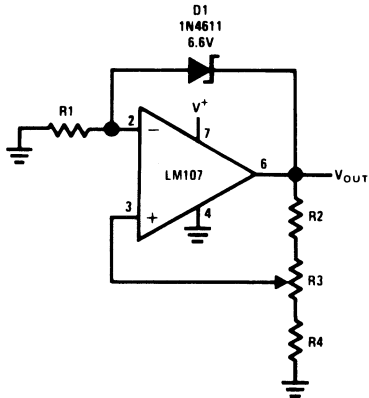


TL/H/7057-35



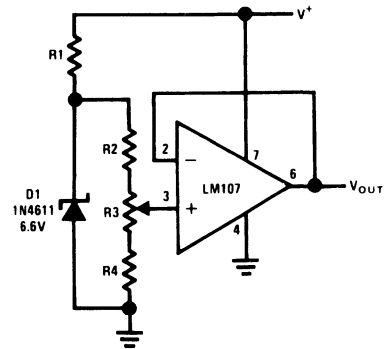
TL/H/7057-91

Positive Voltage Reference



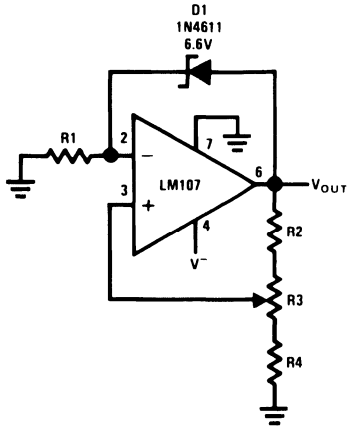
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Positive Voltage Reference



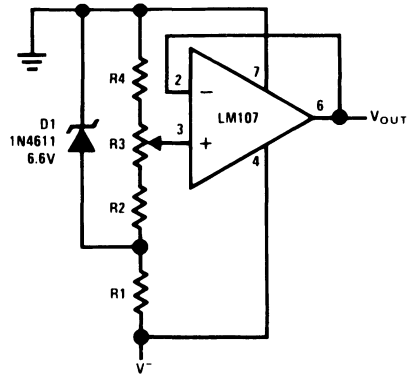
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Negative Voltage Reference



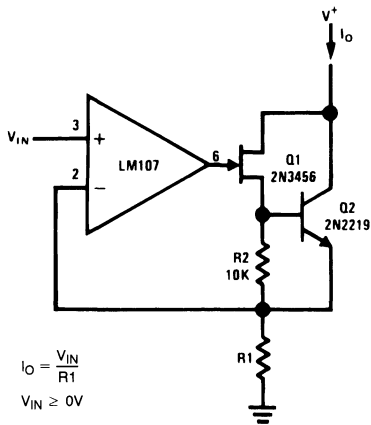
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Negative Voltage Reference



TL/H/7057-39

Precision Current Sink

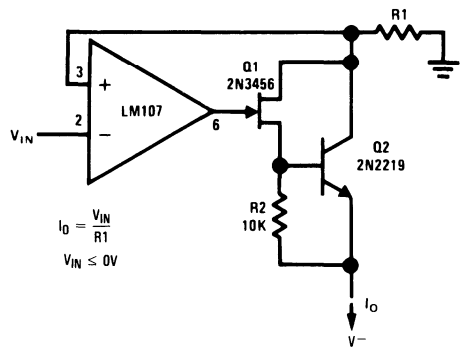


$$I_0 = \frac{V_{IN}}{R_1}$$

$$V_{IN} \geq 0V$$

TL/H/7057-40

Precision Current Source



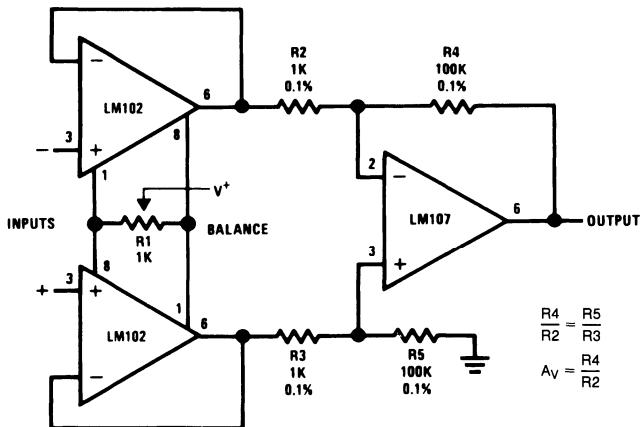
$$I_0 = \frac{V_{IN}}{R_1}$$

$$V_{IN} \leq 0V$$

TL/H/7057-41

SECTION 3 — SIGNAL PROCESSING

Differential-Input Instrumentation Amplifier

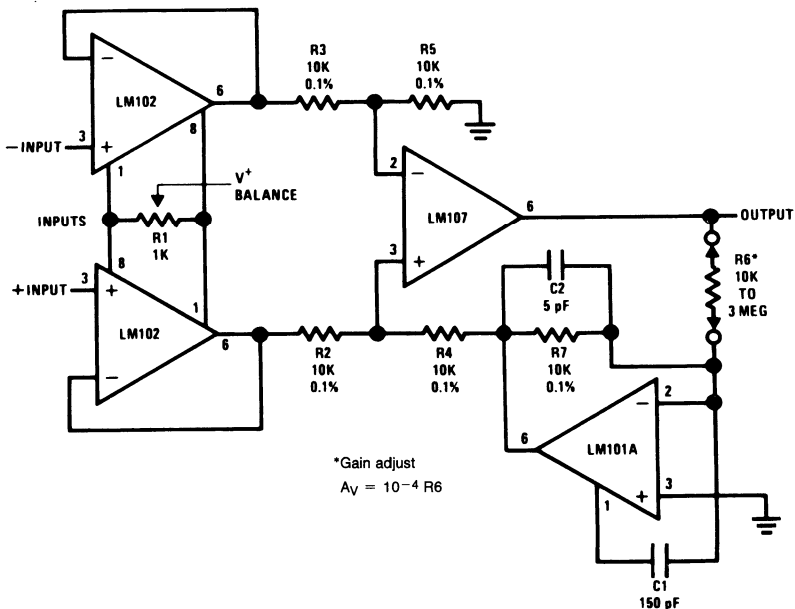


$$\frac{R_4}{R_2} = \frac{R_5}{R_3}$$

$$A_v = \frac{R_4}{R_2}$$

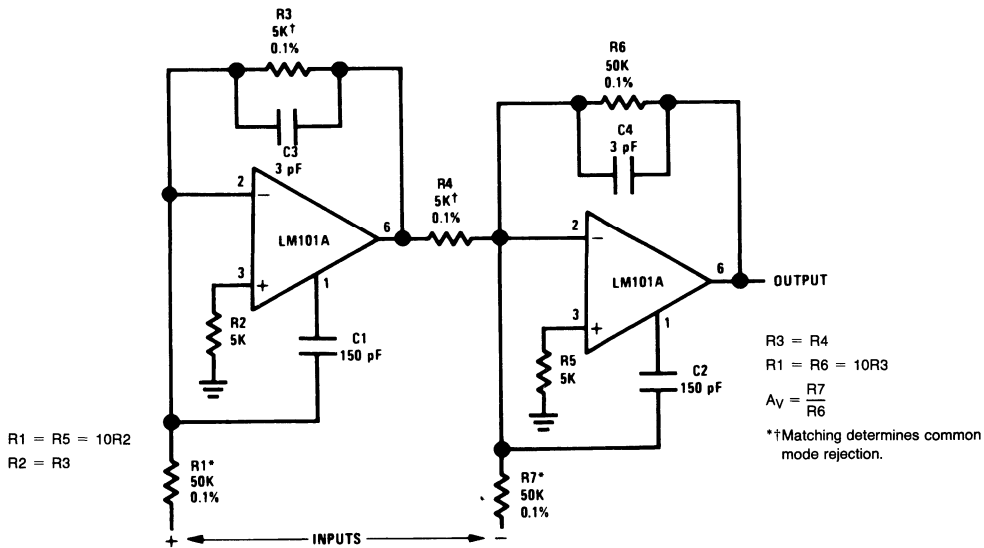
TL/H/7057-42

Variable Gain, Differential-Input Instrumentation Amplifier



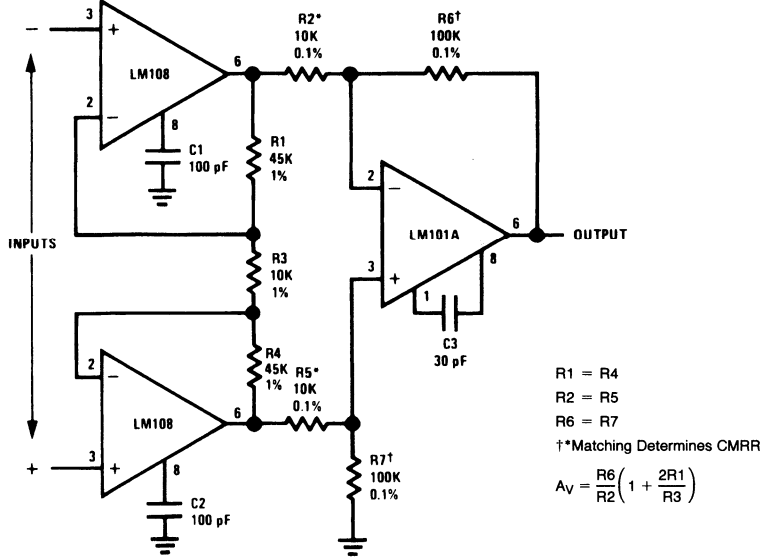
TL/H/7057-43

Instrumentation Amplifier with ± 100 Volt Common Mode Range



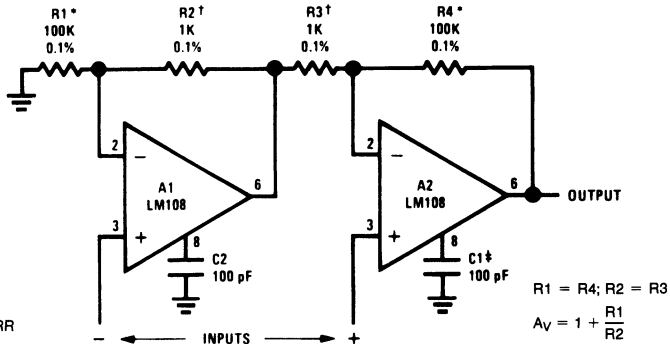
TL/H/7057-44

Instrumentation Amplifier with ± 100 Volt Common Mode Range



TL/H/7057-45

High Input Impedance Instrumentation Amplifier

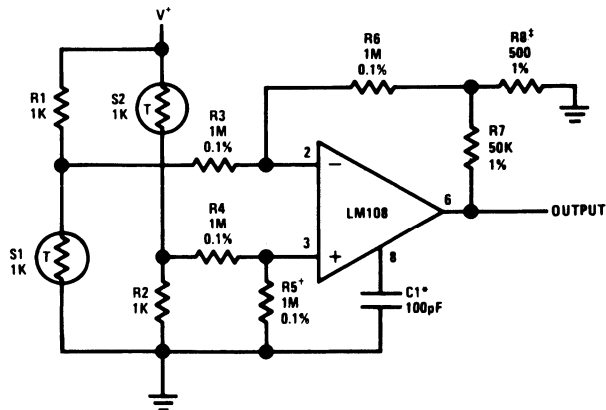


*†Matching determines CMRR

‡May be deleted to maximize bandwidth

TL/H/7057-46

Bridge Amplifier with Low Noise Compensation



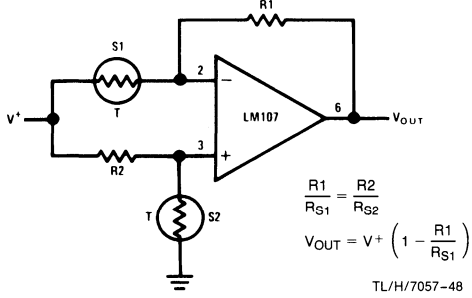
*Reduces feed through of power supply noise by 20 dB and makes supply bypassing unnecessary.

†Trim for best common mode rejection

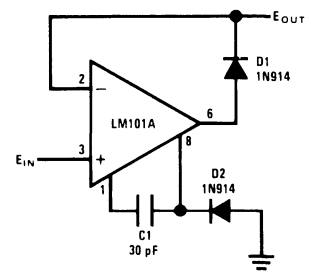
‡Gain adjust

TL/H/7057-47

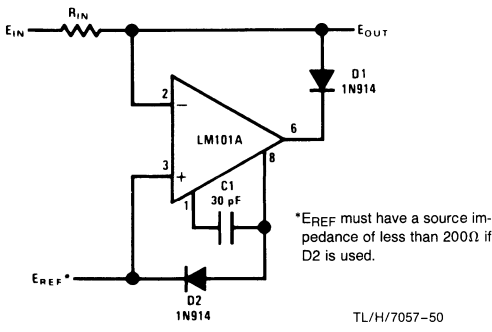
Bridge Amplifier



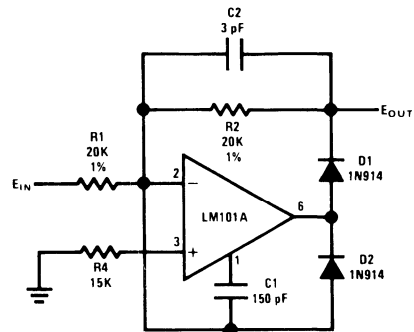
Precision Diode



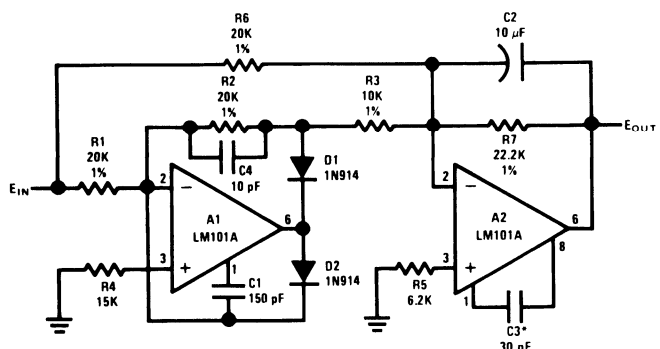
Precision Clamp



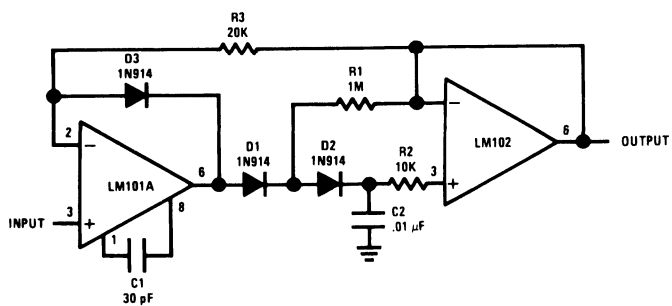
Fast Half Wave Rectifier



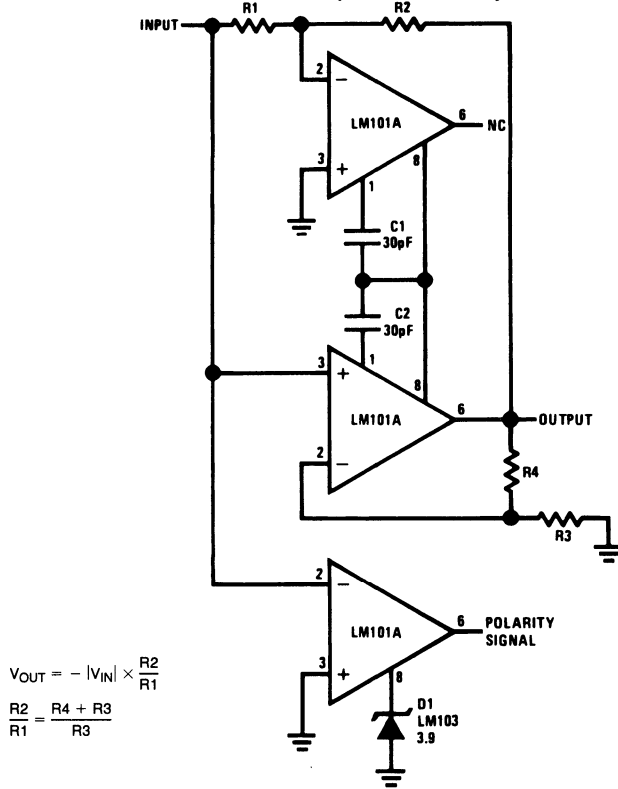
Precision AC to DC Converter



Low Drift Peak Detector

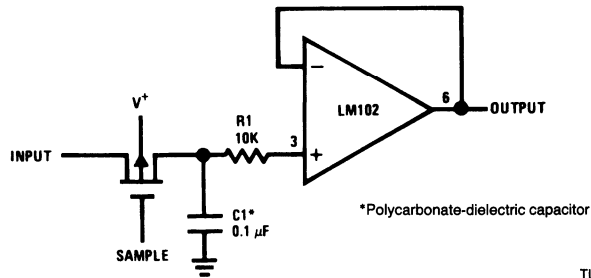


Absolute Value Amplifier with Polarity Detector



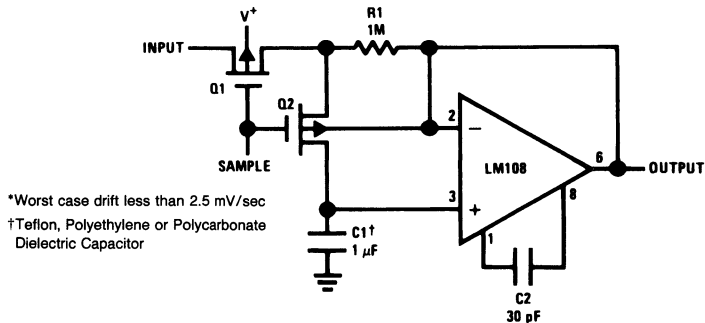
TL/H/7057-54

Sample and Hold



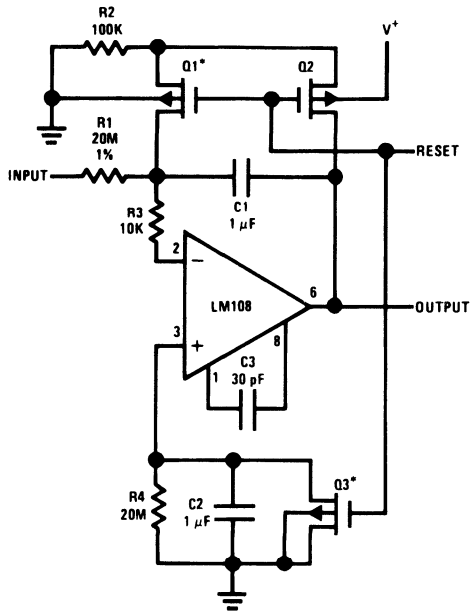
TL/H/7057-55

Sample and Hold



TL/H/7057-56

Low Drift Integrator

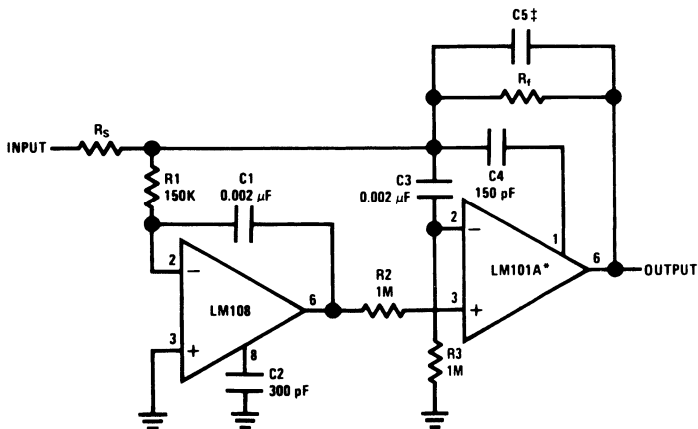


TL/H/7057-57

*Q1 and Q3 should not have internal gate-protection diodes.

Worst case drift less than 500 μV/sec over -55°C to +125°C.

Fast† Summing Amplifier with Low Input Current



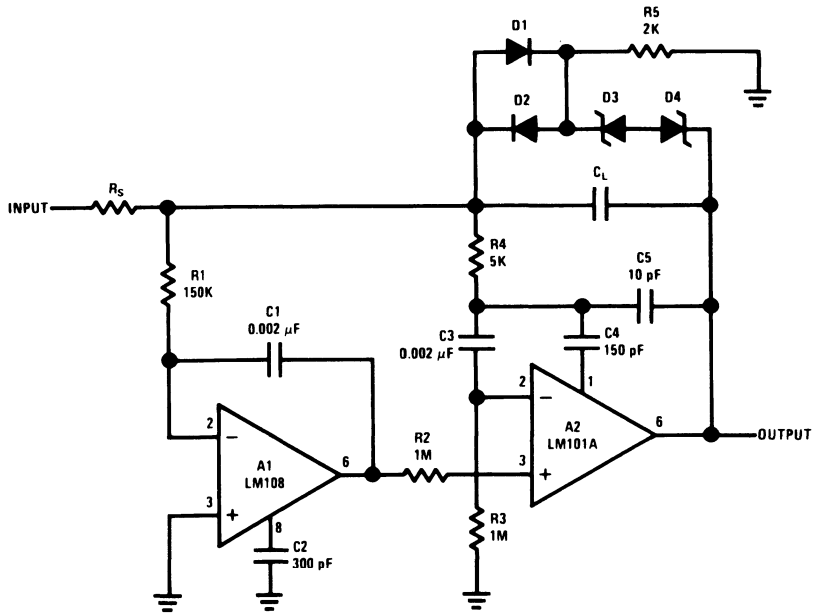
TL/H/7057-58

* In addition to increasing speed, the LM101A raises high and low frequency gain, increases output drive capability and eliminates thermal feedback.

† Power Bandwidth: 250 kHz
 Small Signal Bandwidth: 3.5 MHz
 Slew Rate: 10V/μs

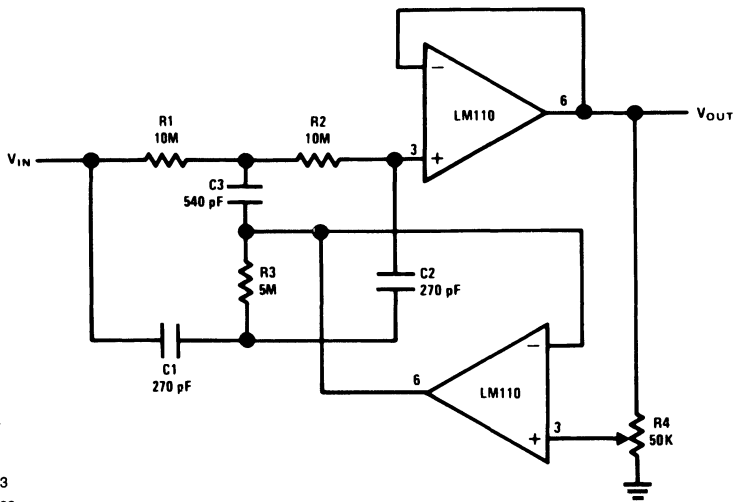
$$\ddagger C5 = \frac{6 \times 10^{-8}}{R_f}$$

Fast Integrator with Low Input Current



TL/H/7057-59

Adjustable Q Notch Filter



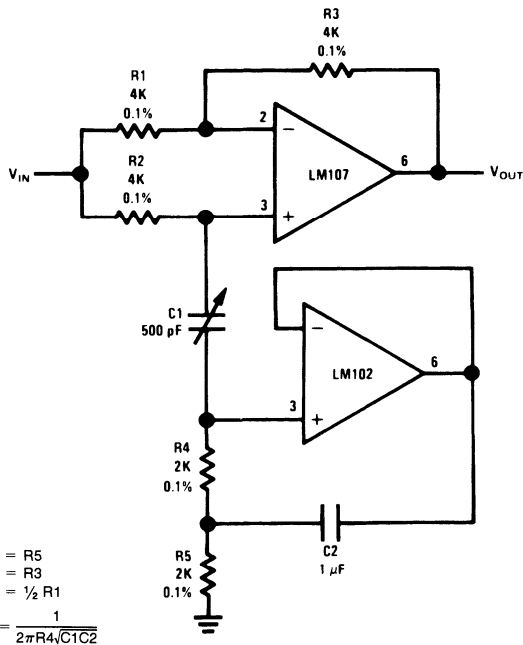
$$f_0 = \frac{1}{2\pi R_1 C_1}$$

$$= 60 \text{ Hz}$$

$R_1 = R_2 = R_3$
 $C_1 = C_2 = C_3$

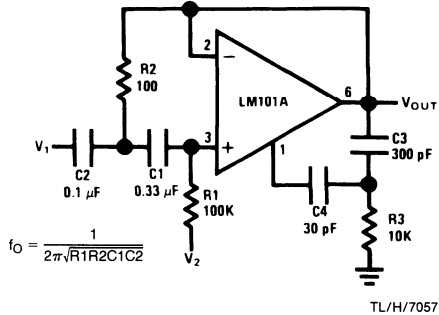
TL/H/7057-60

Easily Tuned Notch Filter

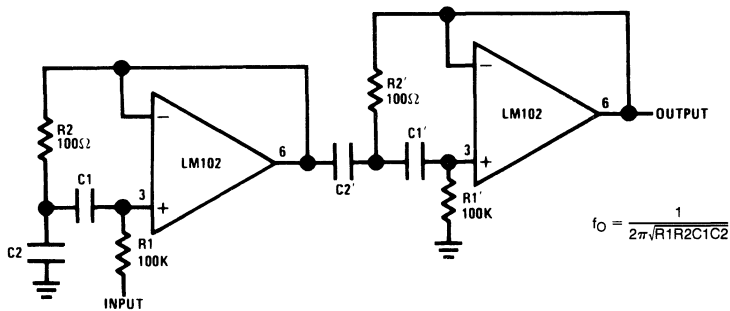


TL/H/7057-61

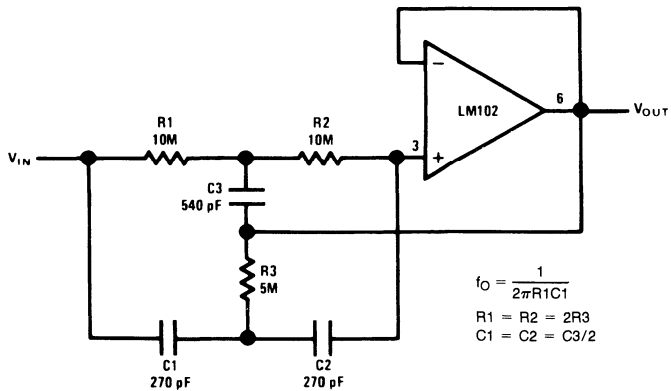
Tuned Circuit



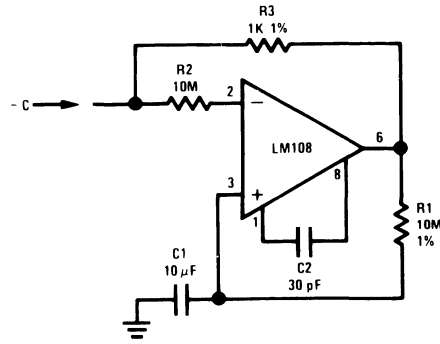
Two-Stage Tuned Circuit



High Q Notch Filter



Negative Capacitance Multiplier



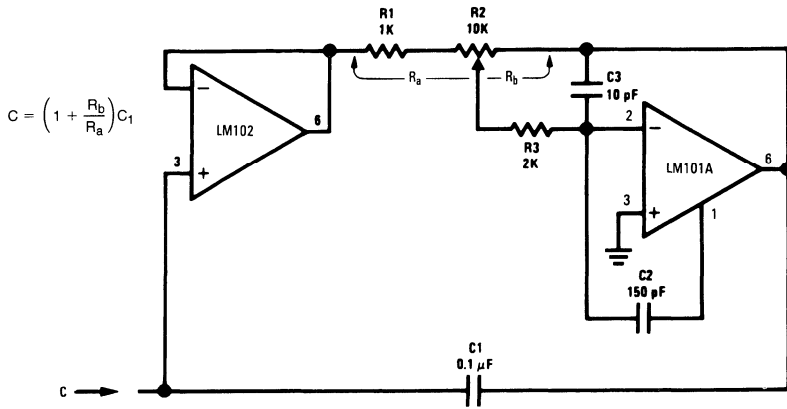
$$C = \frac{R2}{R3} C1$$

$$I_L = \frac{V_{OS} + R2 I_{OS}}{R3}$$

$$R_S = \frac{R3(R1 + R_{IN})}{R_{IN} A_{VO}}$$

TL/H/7057-65

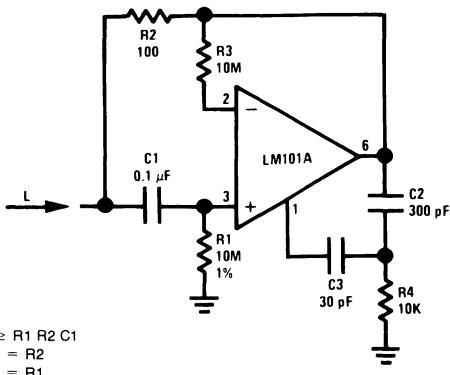
Variable Capacitance Multiplier



$$C = \left(1 + \frac{R_B}{R_A}\right) C1$$

TL/H/7057-66

Simulated Inductor



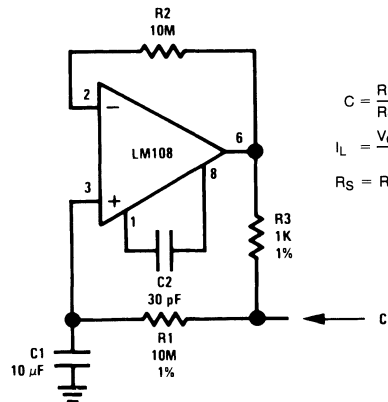
$$L \geq R1 R2 C1$$

$$R_S = R2$$

$$R_P = R1$$

TL/H/7057-67

Capacitance Multiplier



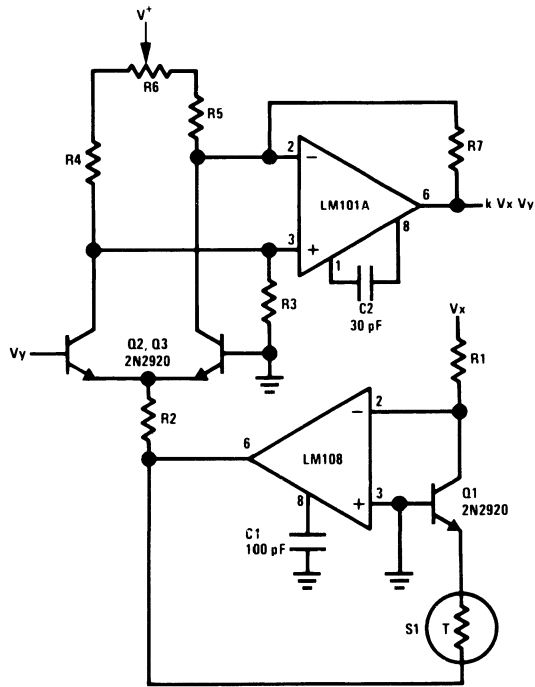
$$C = \frac{R1}{R3} C1$$

$$I_L = \frac{V_{OS} + I_{OS} R1}{R3}$$

$$R_S = R3$$

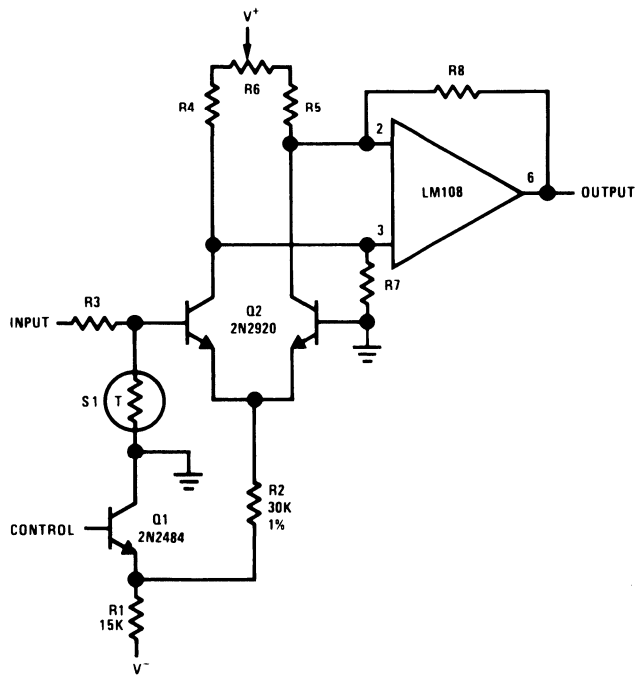
TL/H/7057-68

Two Quadrant Multiplier



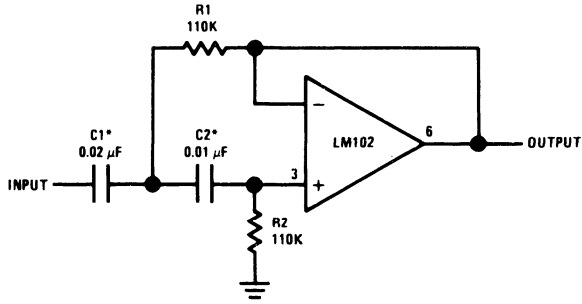
TL/H/7057-69

Voltage Controlled Gain Circuit



TL/H/7057-70

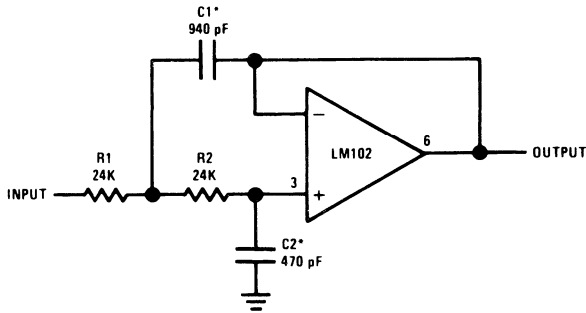
High Pass Active Filter



TL/H/7057-71

*Values are for 100 Hz cutoff. Use metallized polycarbonate capacitors for good temperature stability.

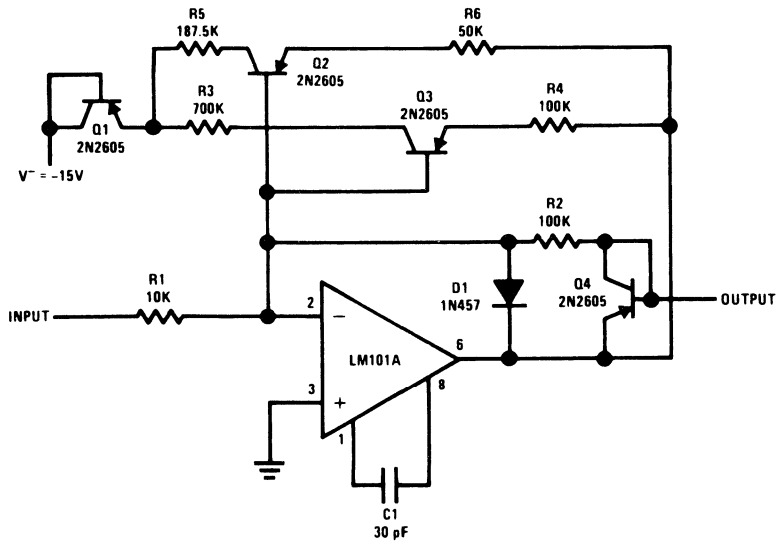
Low Pass Active Filter



TL/H/7057-72

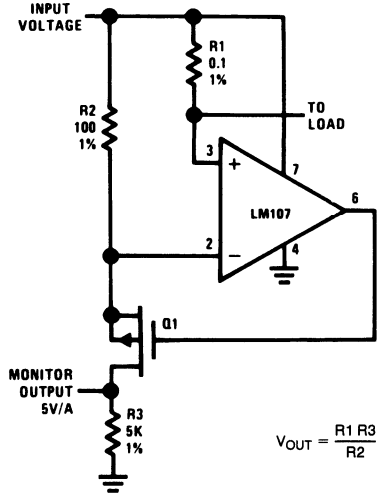
*Values are for 10 kHz cutoff. Use silvered mica capacitors for good temperature stability.

Nonlinear Operational Amplifier with Temperature Compensated Breakpoints



TL/H/7057-73

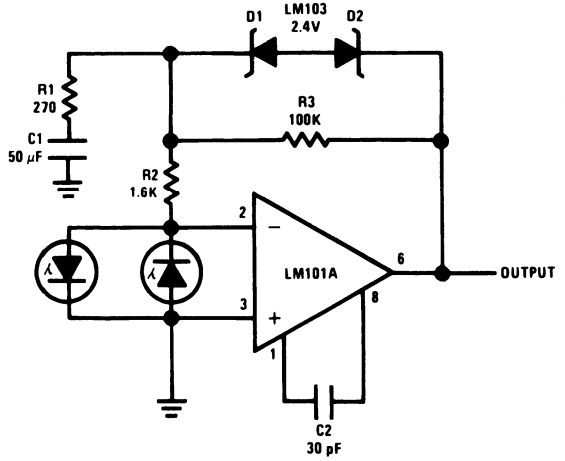
Current Monitor



$$V_{OUT} = \frac{R1 R3}{R2} I_L$$

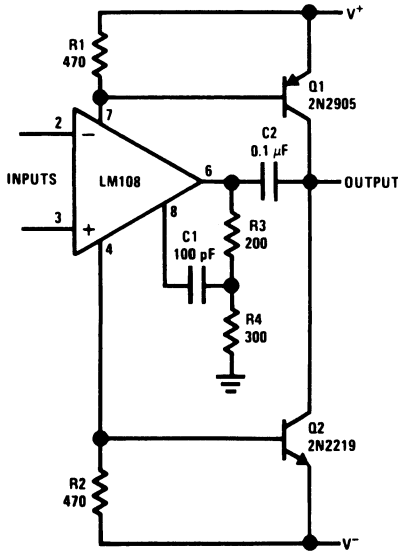
TL/H/7057-74

Saturating Servo Preamp with Rate Feedback



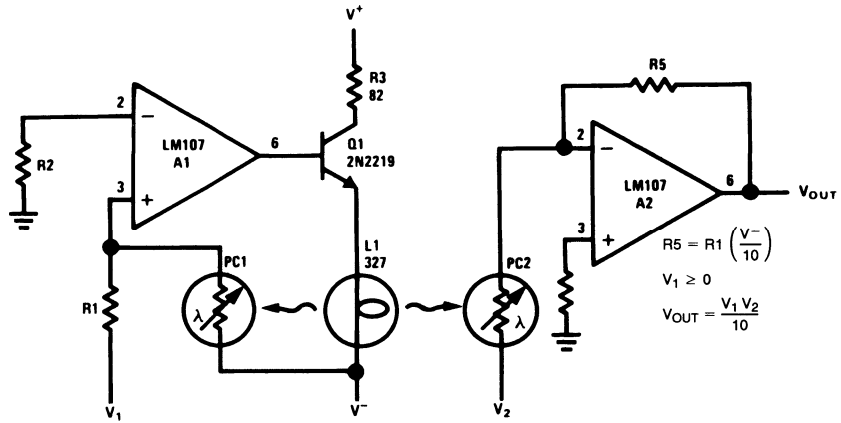
TL/H/7057-75

Power Booster



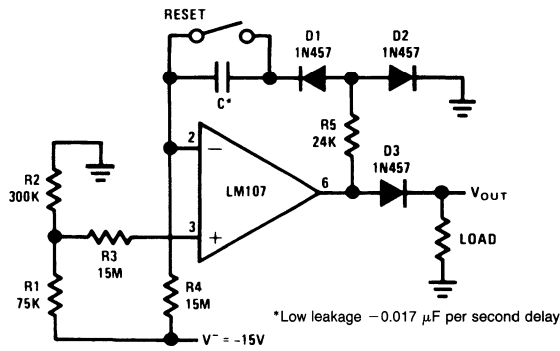
TL/H/7057-76

Analog Multiplier



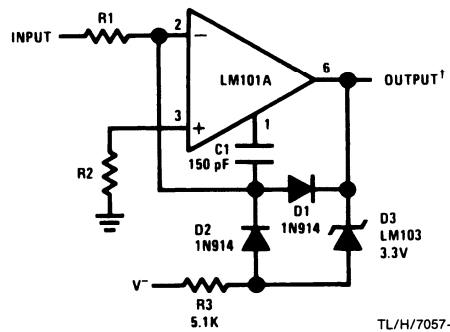
TL/H/7057-77

Long Interval Timer



TL/H/7057-78

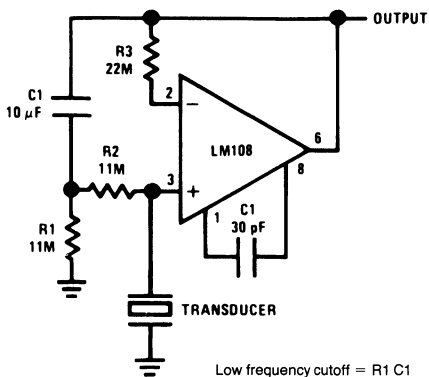
Fast Zero Crossing Detector



TL/H/7057-79

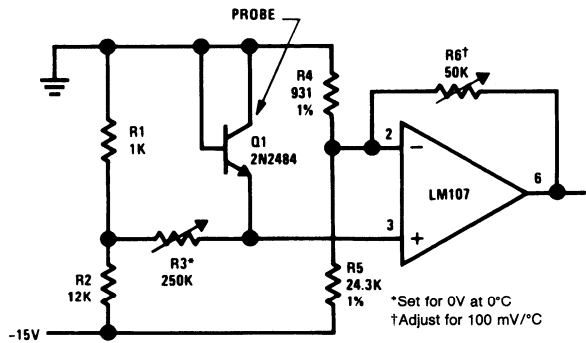
Propagation delay approximately 200 ns
 †DTL or TTL fanout of three.
 Minimize stray capacitance
 Pin 8

Amplifier for Piezoelectric Transducer



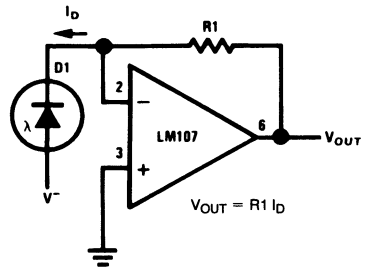
TL/H/7057-80

Temperature Probe



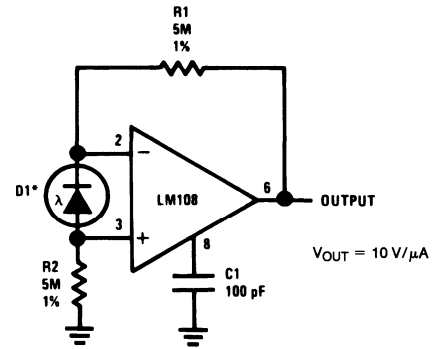
TL/H/7057-81

Photodiode Amplifier



TL/H/7057-82

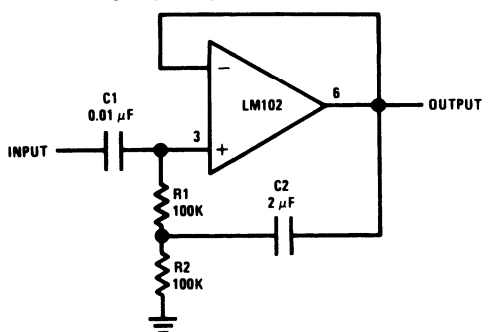
Photodiode Amplifier



TL/H/7057-83

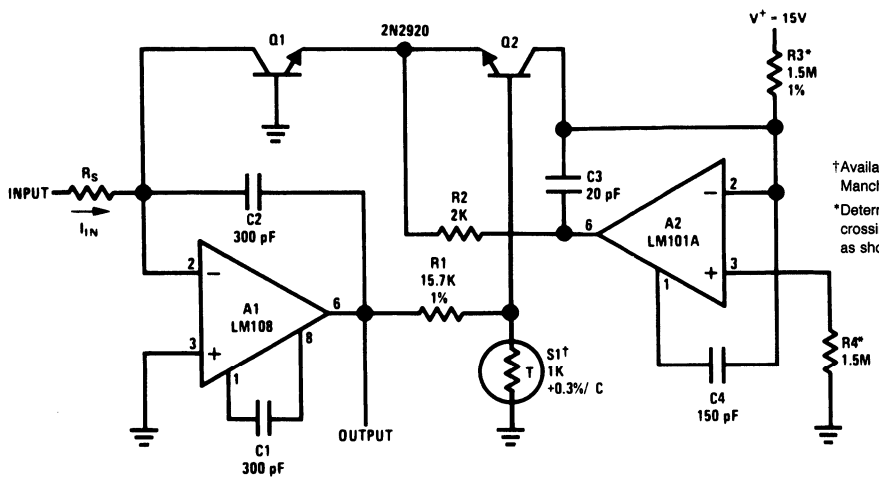
*Operating photodiode with less than 3 mV across it eliminates leakage currents.

High Input Impedance AC Follower



TL/H/7057-84

Temperature Compensated Logarithmic Converter

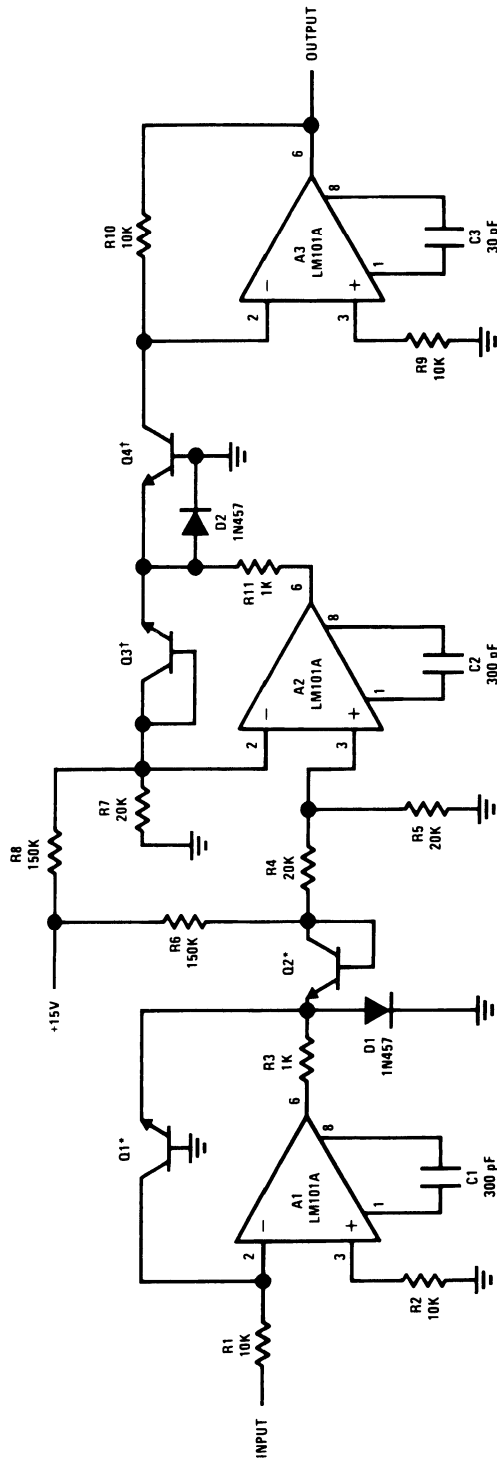


†Available from Tel-Labs, Inc., Manchester, N.H. Type Q81.
*Determines current for zero crossing on output: 10 μA as shown.

TL/H/7057-85

10 nA < IIN < 1 mA
Sensitivity is 1V per decade

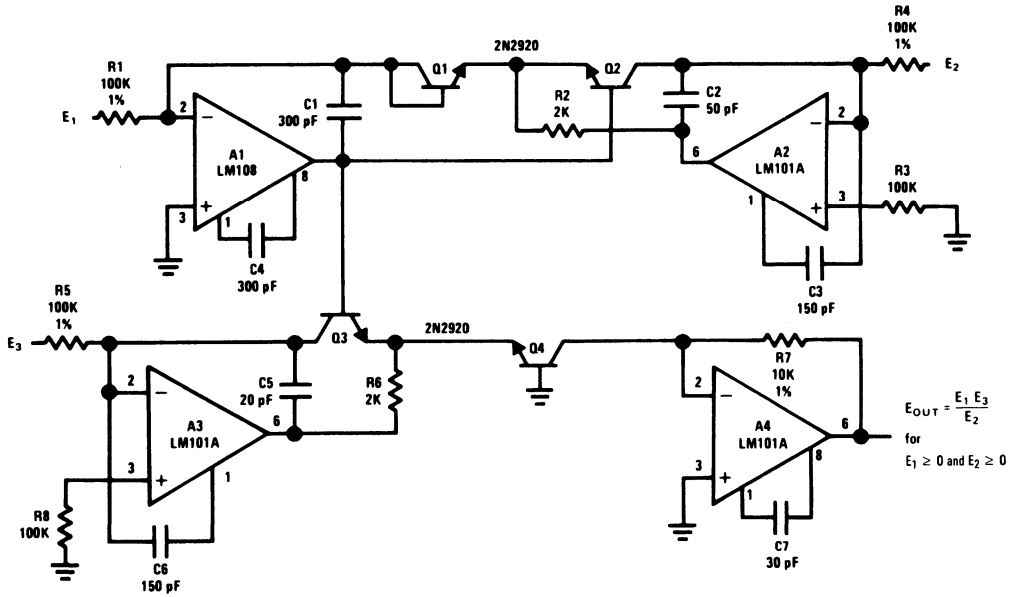
Root Extractor



TL/H/7057-86

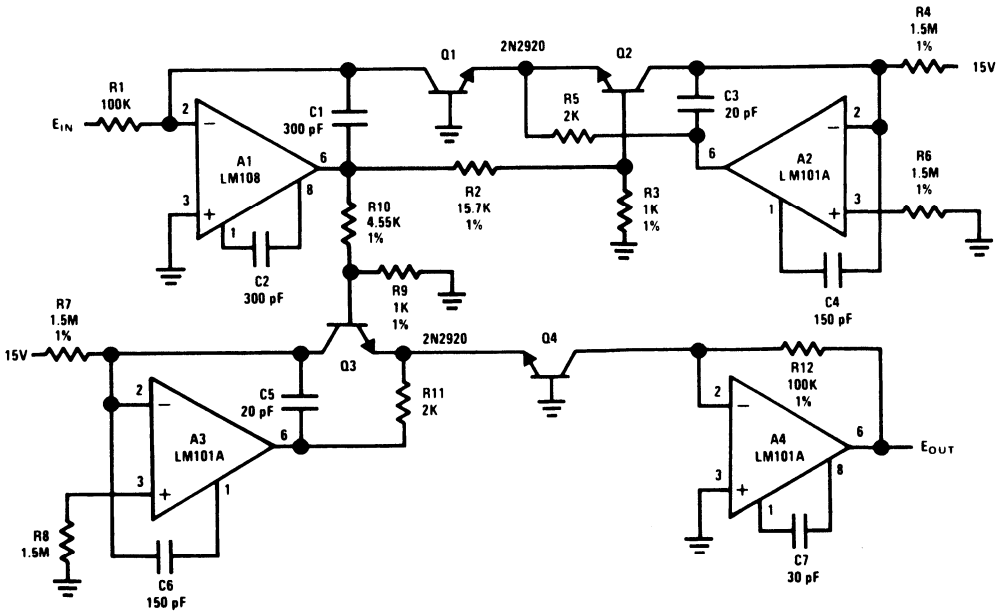
* 2N3728 matched pairs

Multiplier/Divider



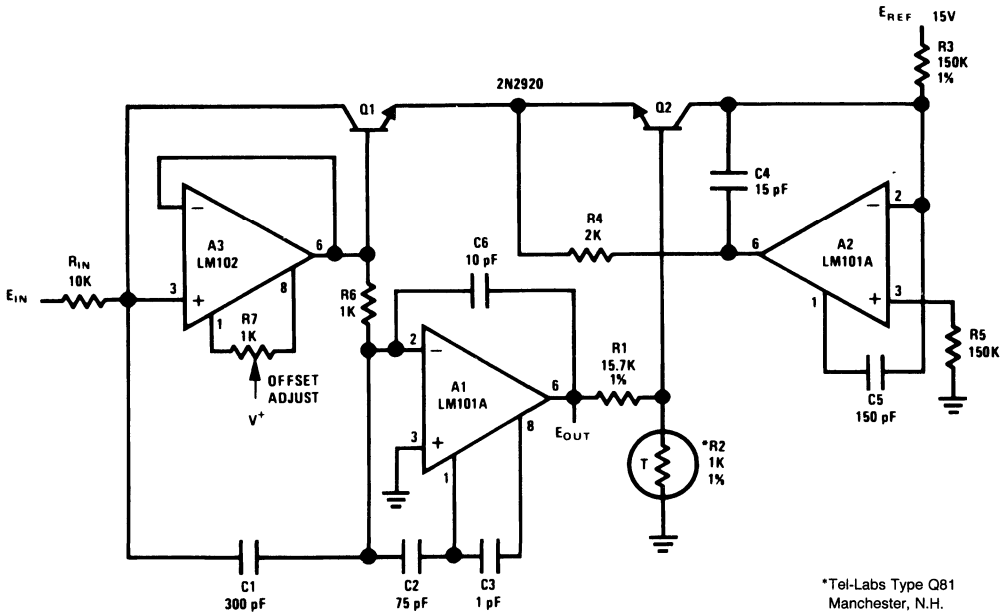
TL/H/7057-87

Cube Generator



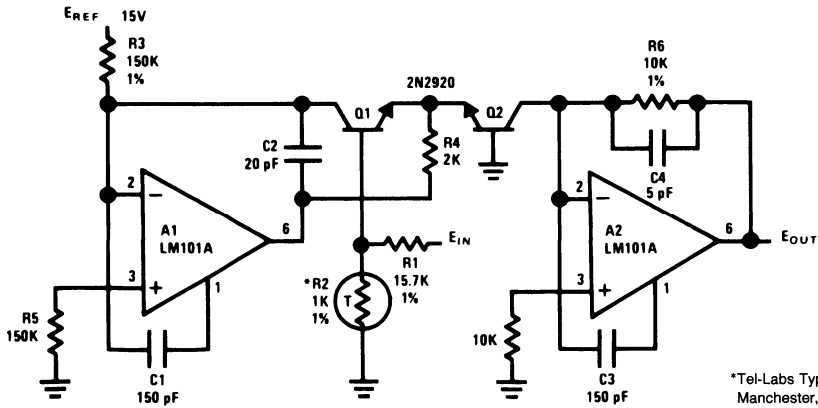
TL/H/7057-88

Fast Log Generator

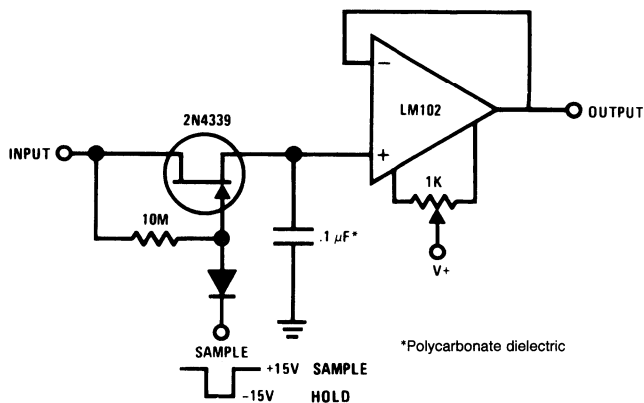


TL/H/7057-89

Anti-Log Generator



TL/H/7057-89



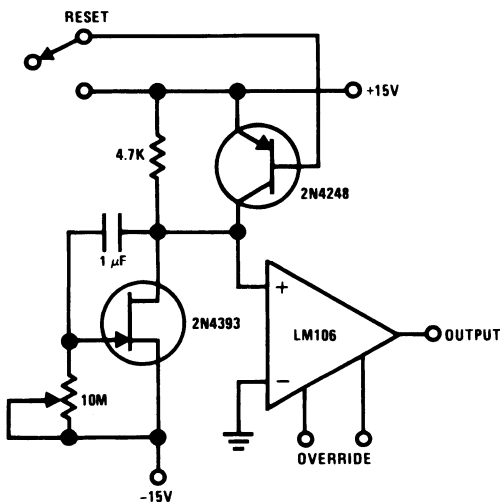
*Polycarbonate dielectric

Sample and Hold With Offset Adjustment

TL/H/6791-1

The 2N4339 JFET was selected because of its low I_{GSS} (< 100 pA), very-low $I_{D(OFF)}$ (< 50 pA) and low pinchoff volt-

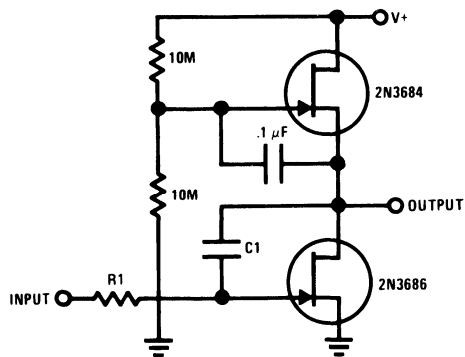
age. Leakages of this level put the burden of circuit performance on clean, solder-resin free, low leakage circuit layout.



Long Time Comparator

TL/H/6791-2

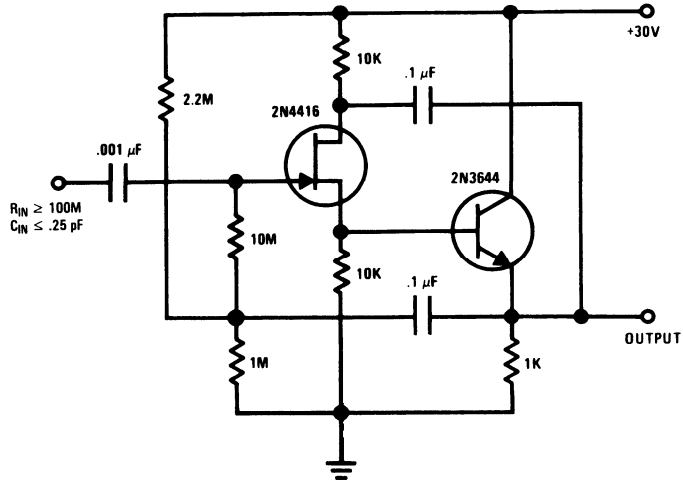
The 2N4393 is operated as a Miller integrator. The high Y_{fs} of the 2N4393 (over 12,000 μmhos @ 5 mA) yields a stage gain of about 60. Since the equivalent capacitance looking into the gate is C times gain and the gate source resistance can be as high as 10 M Ω , time constants as long as a minute can be achieved.



TL/H/6791-3

JFET AC Coupled Integrator

This circuit utilizes the " μ -amp" technique to achieve very high voltage gain. Using C_1 in the circuit as a Miller integrator, or capacitance multiplier, allows this simple circuit to handle very long time constants.

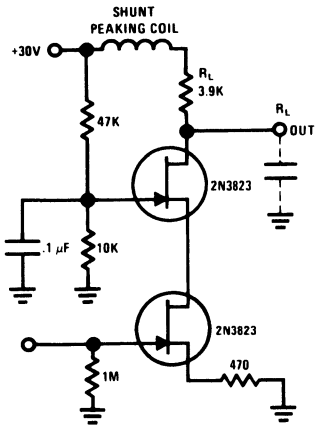


Ultra-High Z_{IN} AC Unity Gain Amplifier

TL/H/6791-4

Nothing is left to chance in reducing input capacitance. The 2N4416, which has low capacitance in the first place, is operated as a source follower with bootstrapped gate bias

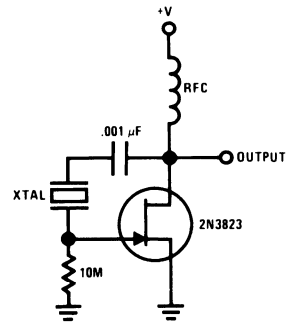
resistor and drain. Any input capacitance you get with this circuit is due to poor layout techniques.



FET Cascode Video Amplifier

TL/H/6791-5

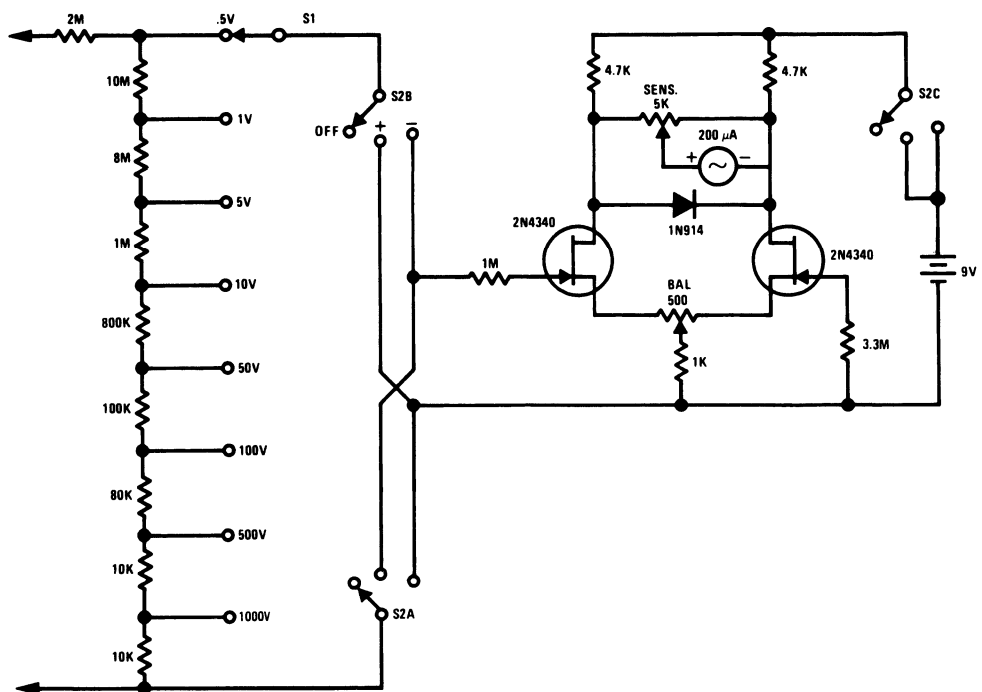
The FET cascode video amplifier features very low input loading and reduction of feedback to almost zero. The 2N3823 is used because of its low capacitance and high Y_{fs} . Bandwidth of this amplifier is limited by R_L and load capacitance.



JFET Pierce Crystal Oscillator

TL/H/6791-6

The JFET Pierce crystal oscillator allows a wide frequency range of crystals to be used without circuit modification. Since the JFET gate does not load the crystal, good Q is maintained thus insuring good frequency stability.

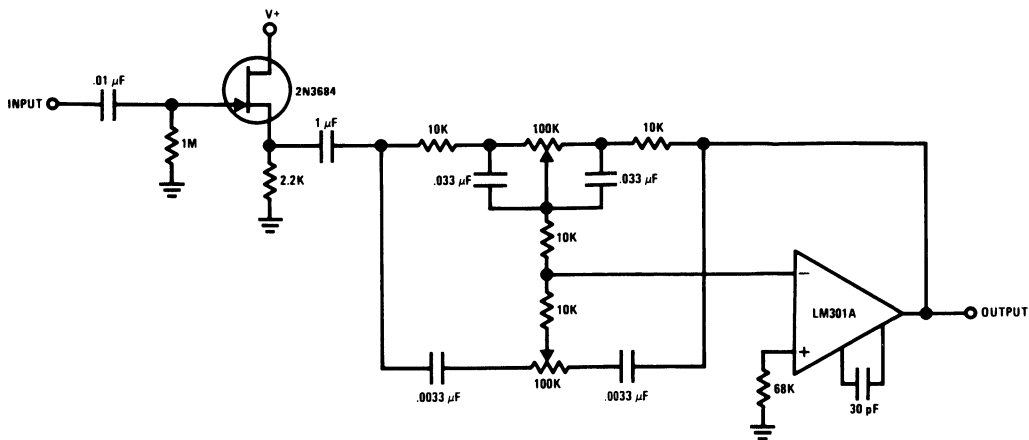


FETVM-FET Voltmeter

TL/H/6791-7

This FETVM replaces the function of the VTVM while at the same time ridding the instrument of the usual line cord. In addition, drift rates are far superior to vacuum tube circuits

allowing a 0.5 volt full scale range which is impractical with most vacuum tubes. The low-leakage, low-noise 2N4340 is an ideal device for this application.

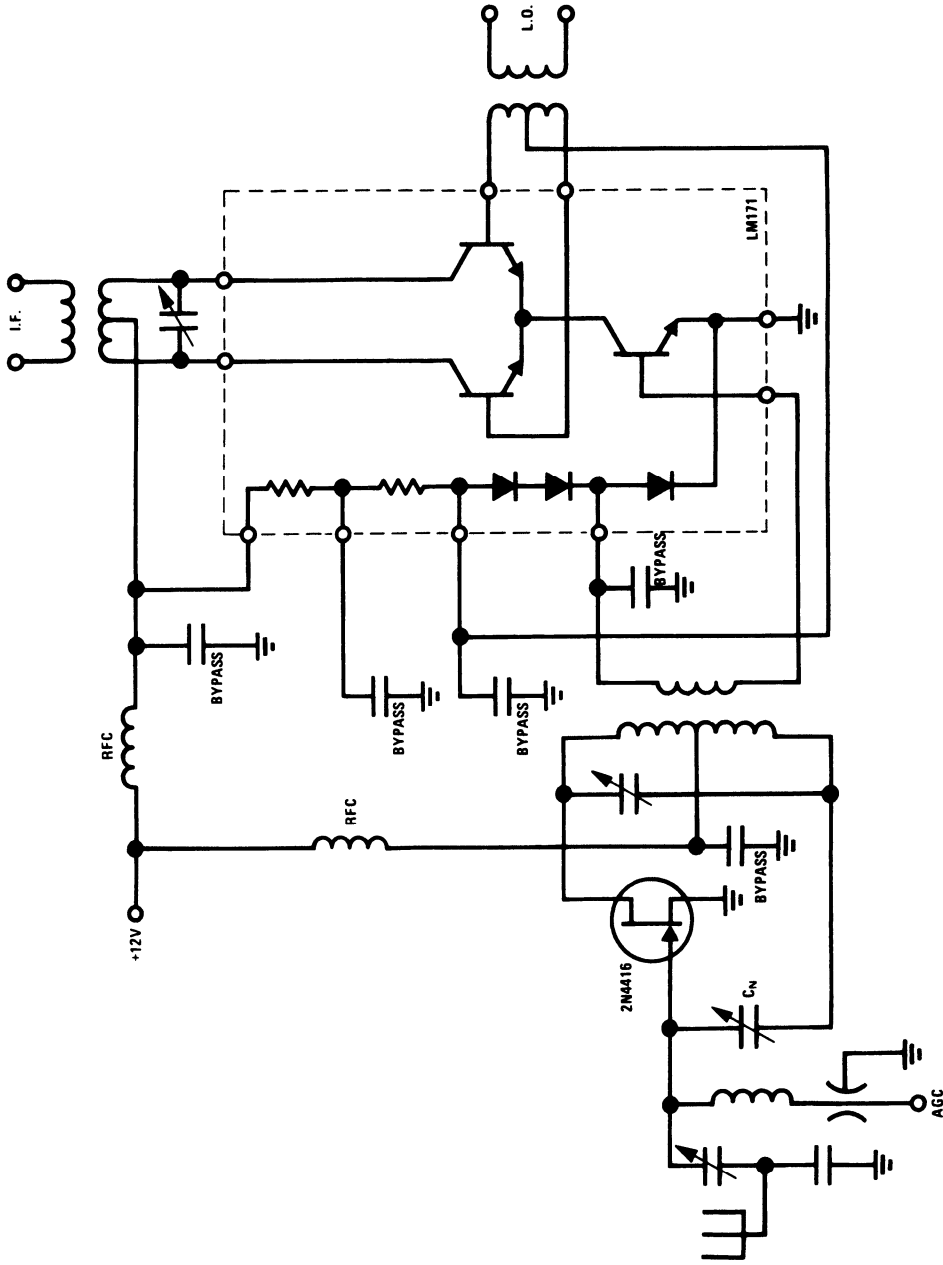


Hi-Fi Tone Control Circuit (High Z Input)

TL/H/6791-8

The 2N3684 JFET provides the function of a high input impedance and low noise characteristics to buffer an op

amp-operated feedback type tone control circuit.

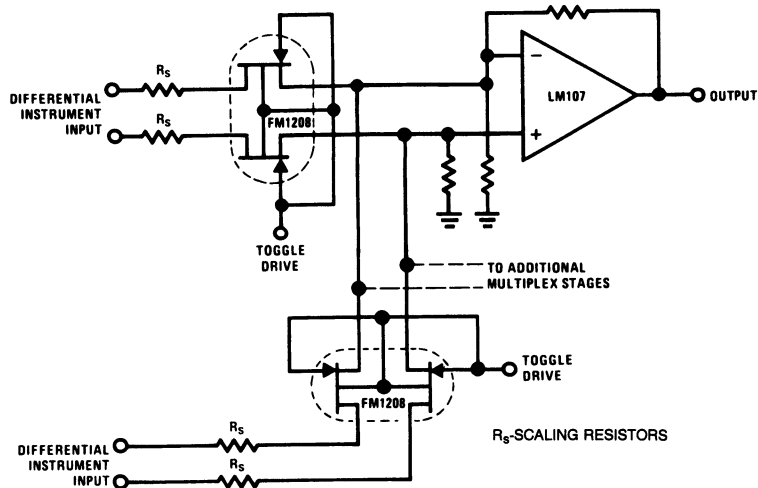


100 MHz Converter

The 2N4416 JFET will provide noise figures of less than 3 dB and power gain of greater than 20 dB. The JFET's outstanding low crossmodulation and low intermodulation distortion provides an ideal characteristic for an input stage.

The output feeds into an LM171 used as a balanced mixer. This configuration greatly reduces L.O. radiation both into the antenna and into the I.F. strip and also reduces RF signal feedthrough.

TL/H/6791-9

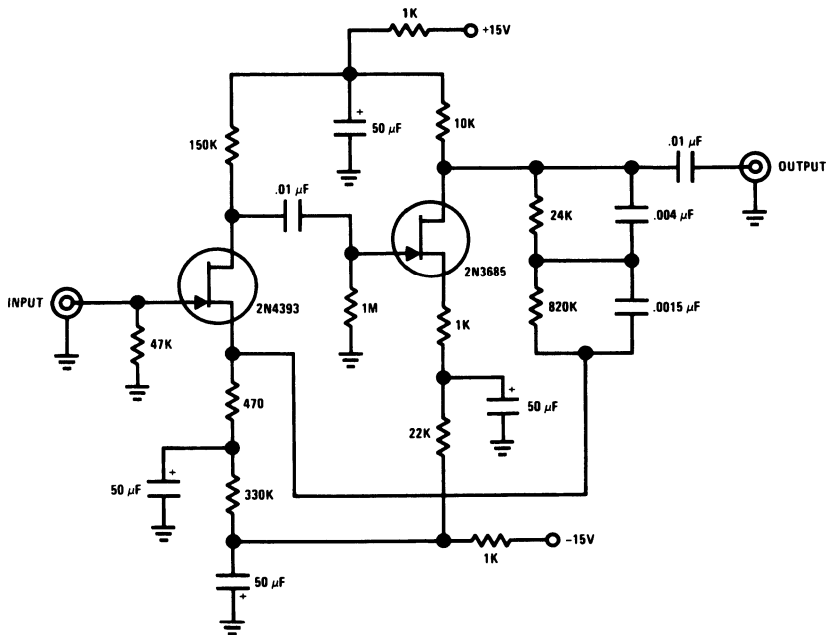


Differential Analog Switch

TL/H/6791-10

The FM1208 monolithic dual is used in a differential multiplexer application where $R_{DS(ON)}$ should be closely matched. Since $R_{DS(ON)}$ for the monolithic dual tracks at better than $\pm 1\%$ over wide temperature ranges

(-25 to $+125^\circ\text{C}$), this makes it an unusual but ideal choice for an accurate multiplexer. This close tracking greatly reduces errors due to common mode signals.

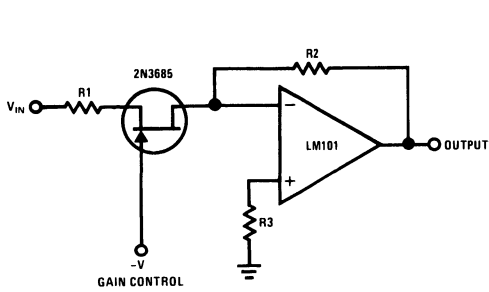


Magnetic-Pickup Phono Preamplifier

TL/H/6791-11

This preamplifier provides proper loading to a reluctance phono cartridge. It provides approximately 25 dB of gain at 1 kHz (2.2 mV input for 100 mV output), it features S + N/N

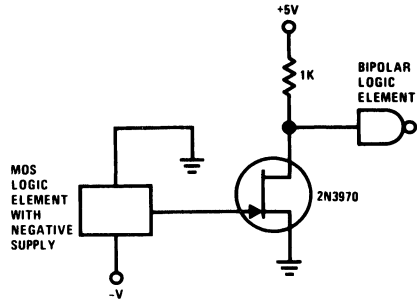
ratio of better than -70 dB (referenced to 10 mV input at 1 kHz) and has a dynamic range of 84 dB (referenced to 1 kHz). The feedback provides for RIAA equalization.



TL/H/6791-12

Variable Attenuator

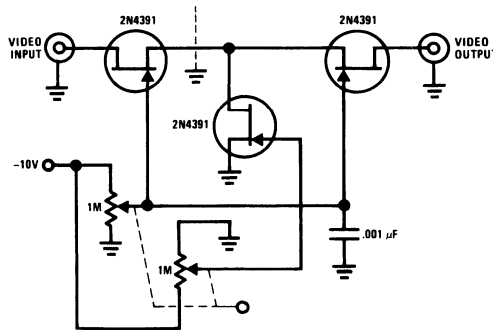
The 2N3685 acts as a voltage variable resistor with an $R_{DS(ON)}$ of 800Ω max. The 2N3685 JFET will have linear resistance over several decades of resistance providing an excellent electronic gain control.



TL/H/6791-13

Negative to Positive Supply Logic Level Shifter

This simple circuit provides for level shifting from any logic function (such as MOS) operating from minus to ground supply to any logic level (such as TTL) operating from a plus to ground supply. The 2N3970 provides a low $r_{DS(ON)}$ and fast switching times.

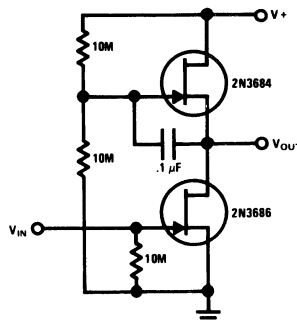


TL/H/6791-14

Voltage Controlled Variable Gain Amplifier

The 2N4391 provides a low $R_{DS(ON)}$ (less than 30Ω). The tee attenuator provides for optimum dynamic linear range for attenuation and if complete turnoff is desired, attenua-

tion of greater than 100 dB can be obtained at 10 MHz providing proper RF construction techniques are employed.



TL/H/6791-15

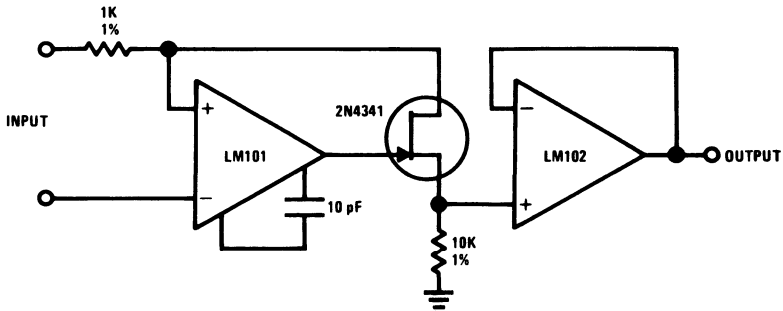
Ultra-High Gain Audio Amplifier

Sometimes called the "JFET" μ amp," this circuit provides a very low power, high gain amplifying function. Since μ of a JFET increases as drain current decreases, the lower drain

current is, the more gain you get. You do sacrifice input dynamic range with increasing gain, however.

$$A_v = \frac{\mu}{2} = 500 \text{ TYPICAL}$$

$$\mu = \frac{Y_{fs}}{Y_{os}}$$

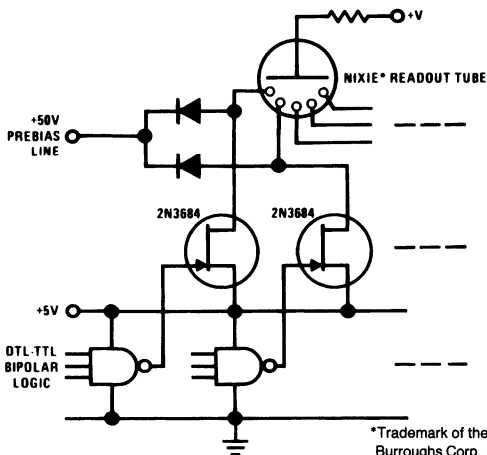


Level-Shifting-Isolation Amplifier

TL/H/6791-16

The 2N4341 JFET is used as a level shifter between two op amps operated at different power supply voltages. The

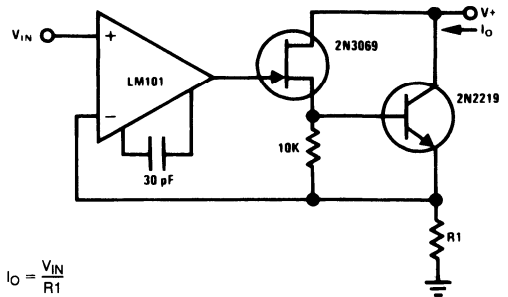
JFET is ideally suited for this type of application because $I_D = I_S$.



FET Nixie* Drivers

*Trademark of the Burroughs Corp.
TL/H/6791-17

The 2N3684 JFETs are used as Nixie tube drivers. Their V_p of 2-5 volts ideally matches DTL-TTL logic levels. Diodes are used to a +50 volt prebias line to prevent breakdown of the JFETs. Since the 2N3684 is in a TO-72 (4 lead TO-18) package, none of the circuit voltages appear on the can. The JFET is immune to almost all of the failure mechanisms found in bipolar transistors used for this application.



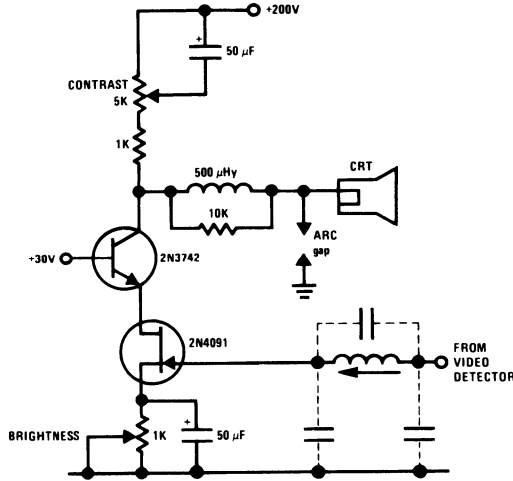
$$I_O = \frac{V_{IN}}{R_1}$$

$V_{IN} > 0V$

TL/H/6791-18

Precision Current Sink

The 2N3069 JFET and 2N2219 bipolar have inherently high output impedance. Using R_1 as a current sensing resistor to provide feedback to the LM101 op amp provides a large amount of loop gain for negative feedback to enhance the true current sink nature of this circuit. For small current values, the 10k resistor and 2N2219 may be eliminated if the source of the JFET is connected to R_1 .

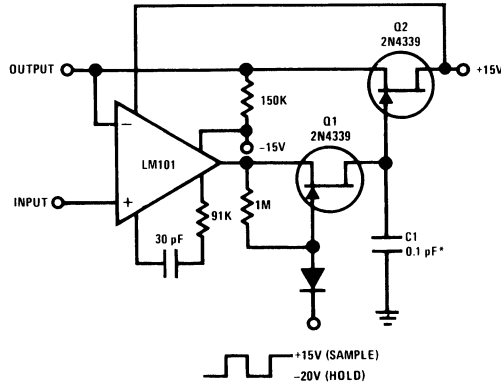


JFET-Bipolar Cascode Circuit

TL/H/6791-19

The JFET-Bipolar cascode circuit will provide full video output for the CRT cathode drive. Gain is about 90. The cascode configuration eliminates Miller capacitance problems with the 2N4091 JFET, thus allowing direct drive from the

video detector. An m derived filter using stray capacitance and a variable inductor prevents 4.5 MHz sound frequency from being amplified by the video amplifier.



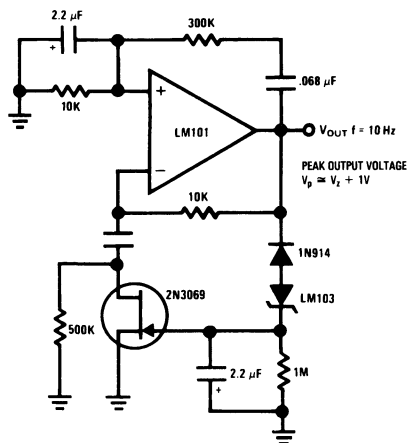
Low Drift Sample and Hold

*Polycarbonate dielectric capacitor

TL/H/6791-20

The JFETs, Q₁ and Q₂, provide complete buffering to C₁, the sample and hold capacitor. During sample, Q₁ is turned on and provides a path, $r_{ds(ON)}$, for charging C₁. During hold, Q₁ is turned off thus leaving Q₁ $I_{D(OFF)}$ (<50 pA)

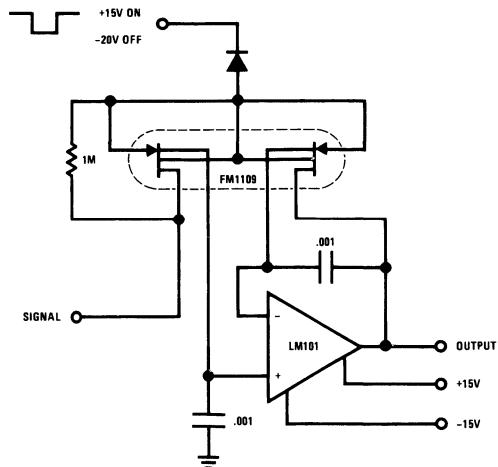
and Q₂ I_{GSS} (<100 pA) as the only discharge paths. Q₂ serves a buffering function so feedback to the LM101 and output current are supplied from its source.



TL/H/6791-21

Wein Bridge Sine Wave Oscillator

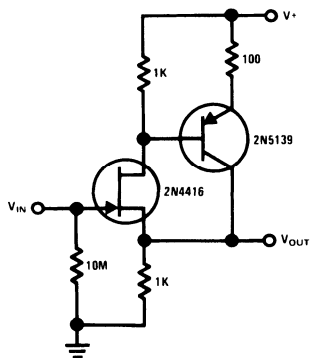
The major problem in producing a low distortion, constant amplitude sine wave is getting the amplifier loop gain just right. By using the 2N3069 JFET as a voltage variable resistor in the amplifier feedback loop, this can be easily achieved. The LM103 zener diode provides the voltage reference for the peak sine wave amplitude; this is rectified and fed to the gate of the 2N3069, thus varying its channel resistance and, hence, loop gain.



TL/H/6791-22

JFET Sample and Hold Circuit

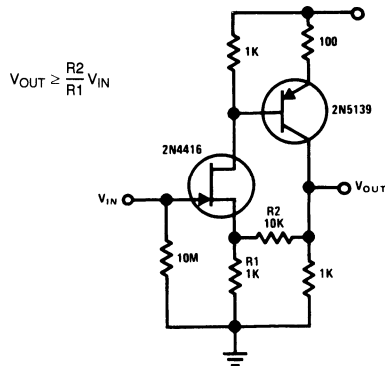
The logic voltage is applied simultaneously to the sample and hold JFETs. By matching input impedance and feedback resistance and capacitance, errors due to $r_{ds(ON)}$ of the JFETs is minimized. The inherent matched $r_{ds(ON)}$ and matched leakage currents of the FM1109 monolithic dual greatly improve circuit performance.



TL/H/6791-23

High Impedance Low Capacitance Wideband Buffer

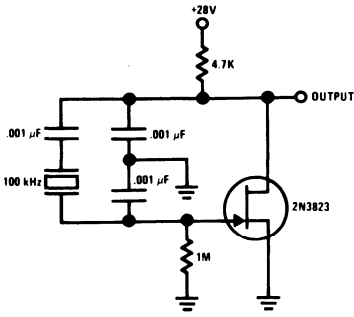
The 2N4416 features low input capacitance which makes this compound-series feedback buffer a wide-band unity gain amplifier.



TL/H/6791-24

High Impedance Low Capacitance Amplifier

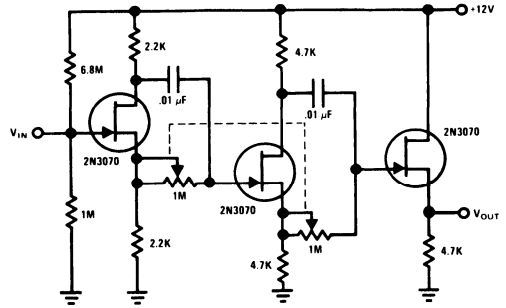
This compound series-feedback circuit provides high input impedance and stable, wide-band gain for general purpose video amplifier applications.



TL/H/6791-25

Stable Low Frequency Crystal Oscillator

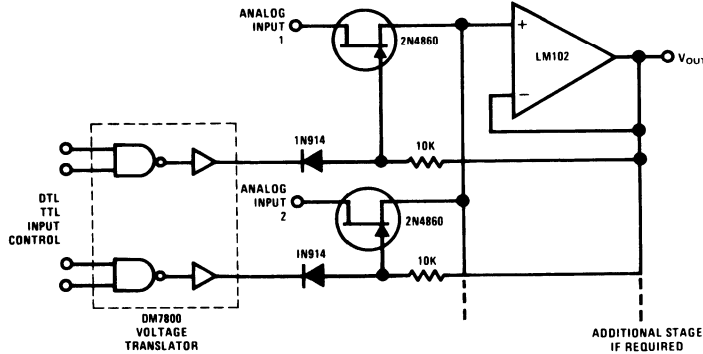
This Colpitts-Crystal oscillator is ideal for low frequency crystal oscillator circuits. Excellent stability is assured because the 2N3823 JFET circuit loading does not vary with temperature.



TL/H/6791-26

0 to 360° Phase Shifter

Each stage provides 0° to 180° phase shift. By ganging the two stages, 0° to 360° phase shift is achieved. The 2N3070 JFETs are ideal since they do not load the phase shift networks.

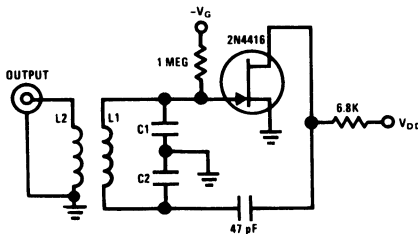


TL/H/6791-27

DTL-TTL Controlled Buffered Analog Switch

This analog switch uses the 2N4860 JFET for its 25 ohm r_{ON} and low leakage. The LM102 serves as a voltage buffer. This circuit can be adapted to a dual trace oscilloscope

chopper. The DM7800 monolithic I.C. provides adequate switch drive controlled DTL-TTL logic levels.



TL/H/6791-28

Low Distortion Oscillator

The 2N4416 JFET is capable of oscillating in a circuit where harmonic distortion is very low. The JFET local oscillator

is excellent when a low harmonic content is required for a good mixer circuit.

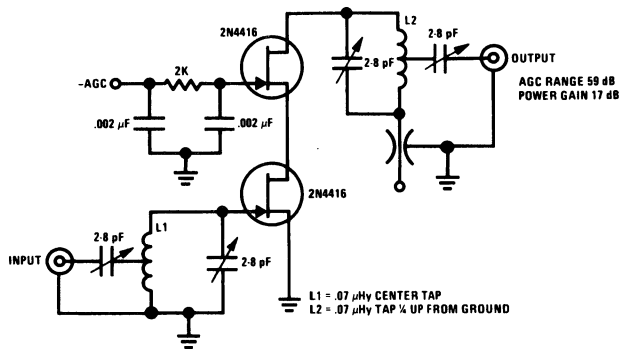
20 MHz OSCILLATOR VALUES

- C1 = 700 pF L1 = 1.3 μH
- C2 = 75 pF L2 = 10T 3/8" DIA 3/4" LONG

V_{DD} = 16V I_D = 1 mA

20 MHz OSCILLATOR PERFORMANCE

- LOW DISTORTION 20 MHz OSC.
- 2ND HARMONIC -60 dB
- 3RD HARMONIC > -70 dB

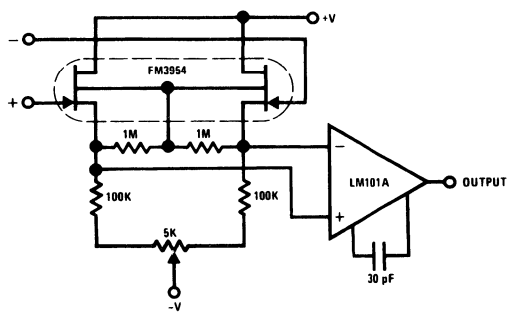


200 MHz Cascode Amplifier

TL/H/6791-29

This 200 MHz JFET cascode circuit features low crossmodulation, large-signal handling ability, no neutralization, and AGC controlled by biasing the upper cascode JFET. The

only special requirement of this circuit is that I_{DSS} of the upper unit must be greater than that of the lower unit.

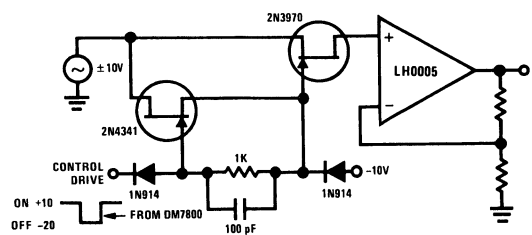


FET Op Amp

TL/H/6791-30

The FM3954 monolithic-dual provides an ideal low-offset, low-drift buffer function for the LM101A op amp. The excellent matching characteristics of the FM3954 track well over

its bias current range thus improving common mode rejection.

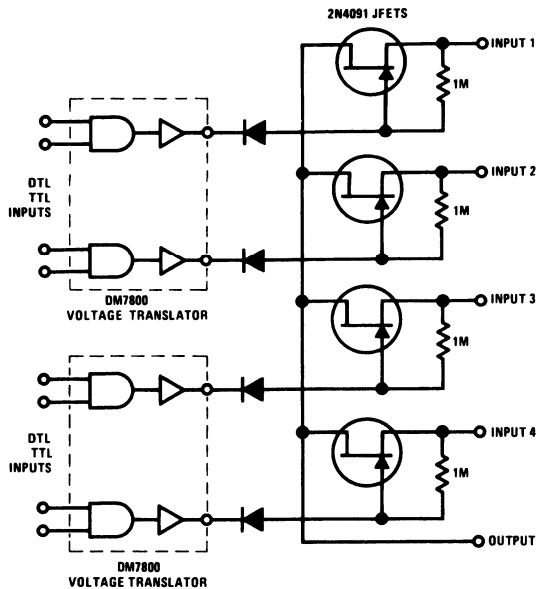


High Toggle Rate High Frequency Analog Switch

TL/H/6791-31

This commutator circuit provides low impedance gate drive to the 2N3970 analog switch for both on and off drive conditions. This circuit also approaches the ideal gate drive conditions for high frequency signal handling by providing a low

ac impedance for off drive and high ac impedance for on drive to the 2N3970. The LH0005 op amp does the job of amplifying megahertz signals.

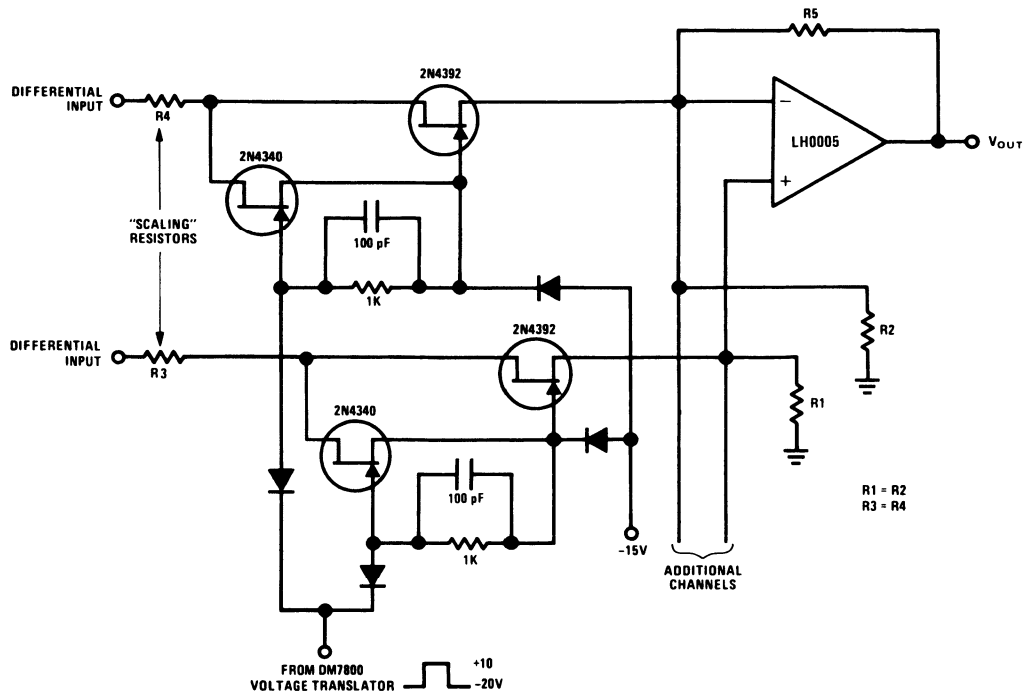


4-Channel Commutator

TL/H/6791-32

This 4-channel commutator uses the 2N4091 to achieve low channel ON resistance ($<30\Omega$) and low OFF current leakage. The DM7800 voltage translator is a monolithic device

which provides from +10V to -20V gate drive to the JFETs while at the same time providing DTL-TTL logic compatibility.

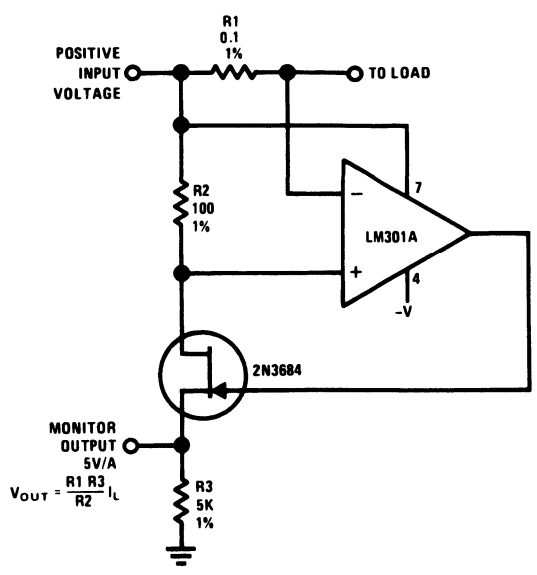


Wide Band Differential Multiplexer

TL/H/6791-33

This design allows high frequency signal handling and high toggle rates simultaneously. Toggle rates up to 1 MHz and

MHz signals are possible with this circuit.

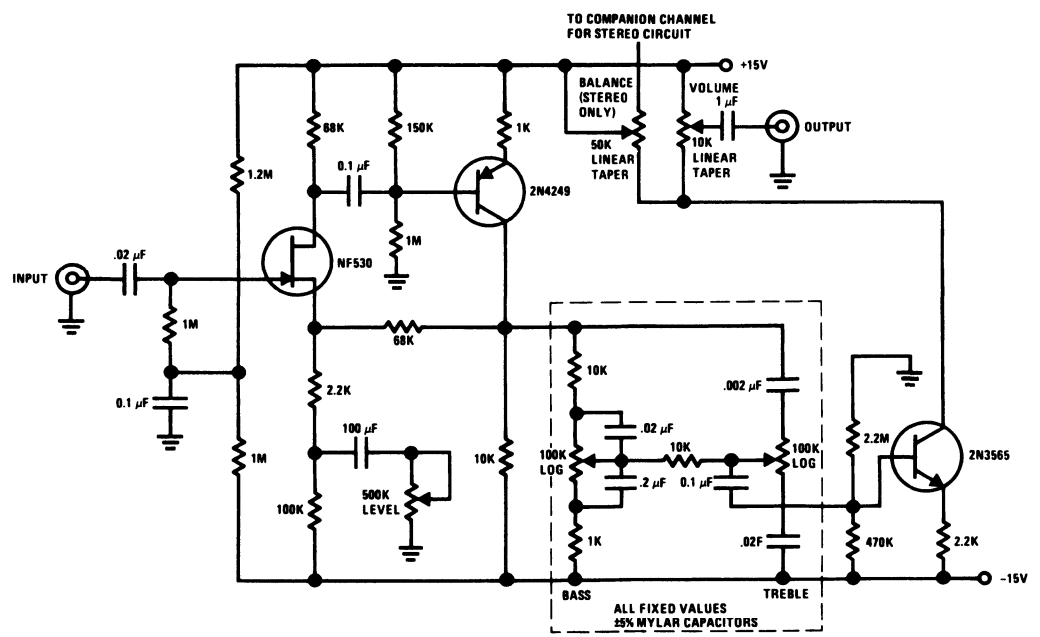


TL/H/6791-34

Current Monitor

R₁ senses current flow of a power supply. The JFET is used as a buffer because I_D = I_S, therefore the output monitor

voltage accurately reflects the power supply current flow.

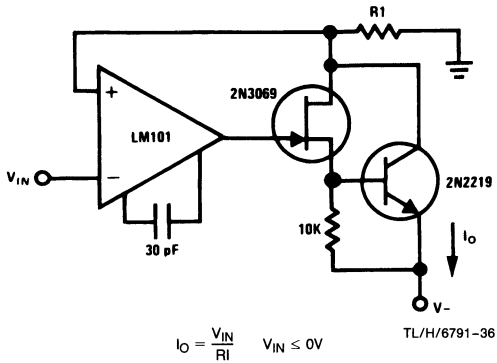


TL/H/6791-35

Low Cost High Level Preamp and Tone Control Circuit

This preamp and tone control uses the JFET to its best advantage; as a low noise high impedance device. All device parameters are non-critical yet the circuit achieves harmonic distortion levels of less than 0.05% with a S/N

ratio of over 85 dB. The tone controls allow 18 dB of cut and boost; the amplifier has a 1 volt output for 100 mV input at maximum level.

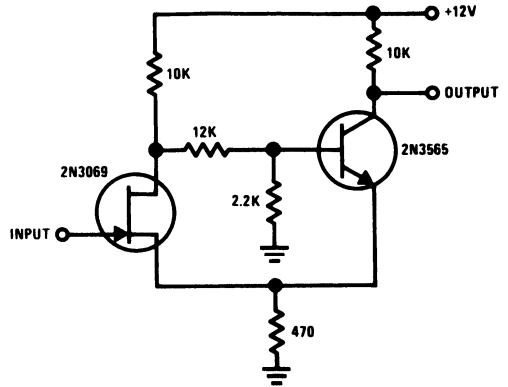


$$I_o = \frac{V_{IN}}{R1} \quad V_{IN} \leq 0V$$

TL/H/6791-36

Precision Current Source

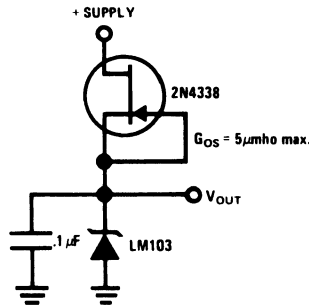
The 2N3069 JFET and 2N2219 bipolar serve as voltage devices between the output and the current sensing resistor, R₁. The LM101 provides a large amount of loop gain to assure that the circuit acts as a current source. For small values of current, the 2N2219 and 10k resistor may be eliminated with the output appearing at the source of the 2N3069.



TL/H/6791-37

Schmitt Trigger

This Schmitt trigger circuit is "emitter coupled" and provides a simple comparator action. The 2N3069 JFET places very little loading on the measured input. The 2N3565 bipolar is a high h_{FE} transistor so the circuit has fast transition action and a distinct hysteresis loop.

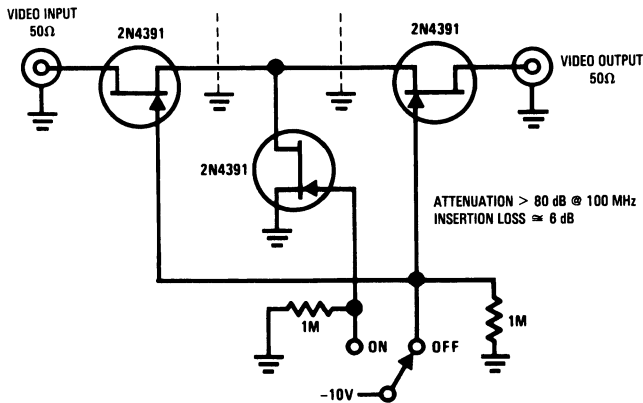


TL/H/6791-38

Low Power Regulator Reference

This simple reference circuit provides a stable voltage reference almost totally free of supply voltage hash. Typical

power supply rejection exceeds 100 dB.



TL/H/6791-39

High Frequency Switch

The 2N4391 provides a low on-resistance of 30 ohms and a high off-impedance (<0.2 pF) when off. With proper layout

and an "ideal" switch, the performance stated above can be readily achieved.

Applications of MOS Analog Switches

National Semiconductor
Application Note 38
R. Stump
D. Wollesen



ABSTRACT

This discussion begins with some basic commutation circuits, then describes some uses in linear amplifier applications such as reset functions and chopper applications. The use of MOS switches as a suppressed carrier double-sideband modulator and a double-sideband demodulator is then covered; followed by a circuit proposal for a phase-locked loop AM-FM detector without tuned circuits.

THE MOS DIFFERENTIAL SWITCH—DC TO RF

The dual differential switch is a particular switch connection scheme which at first glance prompts one to say—so what? It is, however, one of those simple circuit configurations which can find a wide variety of uses in electronic circuits. The dual differential switch could also be called a DPDT switch or two DPDT switches—depending on how they are toggled.

MOS switches have some unique features which make them very useful for data switching^{1,2,3}: no offset voltage, high R_{OFF}/R_{ON} ratios, low leakage, fast operation, and matched “on” resistance. Within definite bounds, MOS switches exhibit good isolation between the switching drive and signal path.

MOS switches do have somewhat unique driving requirements. In order to solve this problem, National manufactures a hybrid integrated circuit which provides DTL-TTL drive compatibility with the dual differential switch. These devices use the DM7801 chip with an MM450 chip for the AH0014 and the DM7800 chip with an MM450 chip for the AH0019.

The AH0014 is basically a DPDT switch while the AH0019 is two SPDT switches in the same package. Each connection has its particular advantages and disadvantages.

COMMUTATION CIRCUITS

The AH0014 may be used as a two channel commutator only, because two of its four channels are always on. The AH0019 may be used for systems with any number of channels since it can shut all channels off on command.

Figure 3 shows a six channel commutator which may be easily expanded. Data sampling may be done on any format which the user chooses. Sampling format is easily controlled by DTL or TTL logic design independent of the AH0019. Since each buffer-driver of the AH0019 has a dual input gate, all channel blanking is readily achieved. If desired, the format shown in *Figure 3* may be modified so as to use the AH0019 logic inputs as binary gates which can reduce the command logic complexity if the blanking function is not required.

Since the multiplexed information is in differential form, common mode noise is greatly reduced. Also, the MOS gate drive spiking is drastically reduced because of the differential channel configuration. Demultiplexing may be accomplished by using a circuit identical to the multiplexer because the MOS device is a true bilateral switch. In hardwired systems where the multiplex “outputs” are electrically connected as in *Figure 4*, the signal may be transmitted in either direction. For non-hardwired systems, the modulation-demodulation sequence is still bilateral, but provisions must be made for transmit/receive function control.

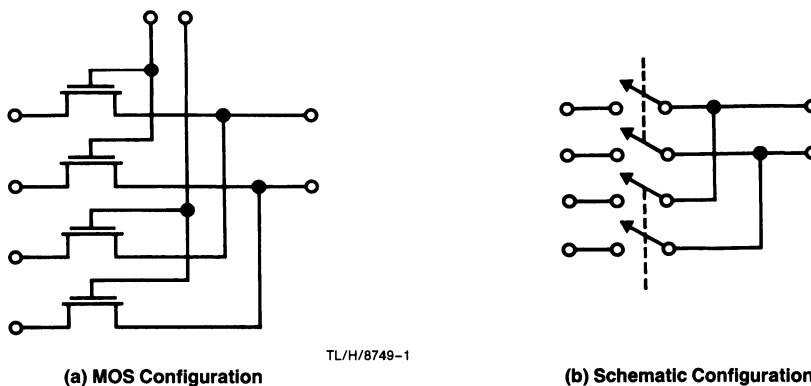
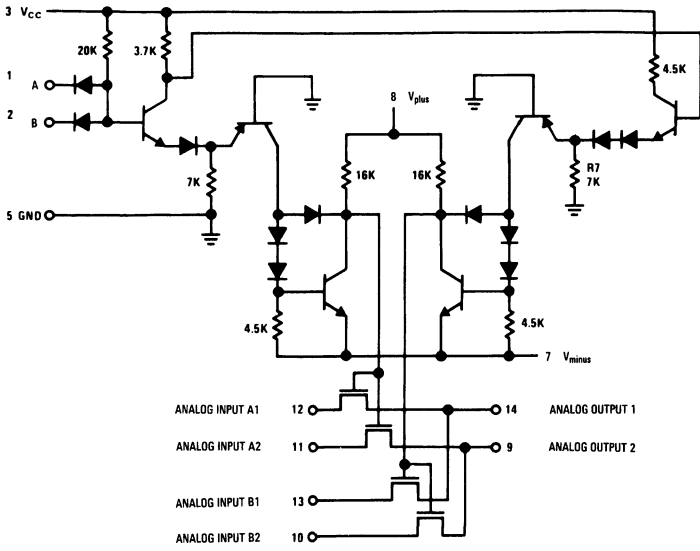


FIGURE 1. MM450/MM550 MOS Dual Differential Switch

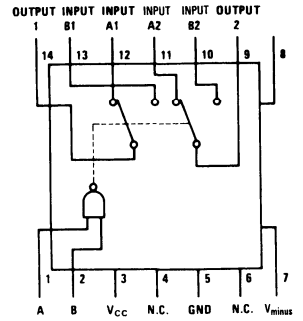


ANALOG INPUT A1 12
 ANALOG INPUT A2 11
 ANALOG INPUT B1 13
 ANALOG INPUT B2 10

ANALOG OUTPUT 1 14
 ANALOG OUTPUT 2 9

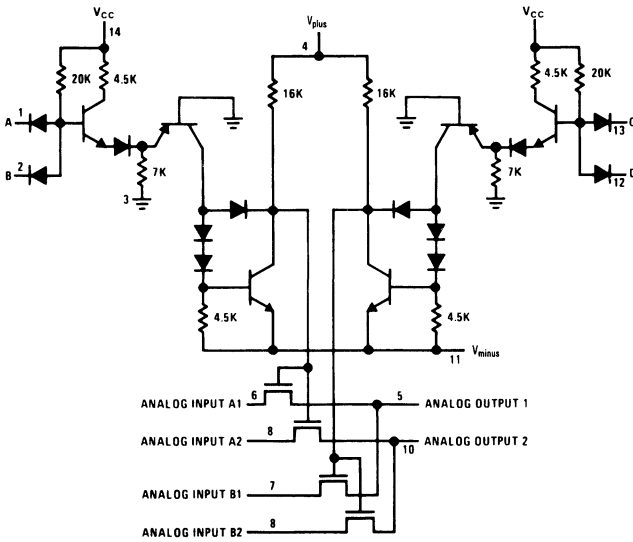
(a) AH0014

TL/H/8749-3



Note: All inputs "HIGH"

TL/H/8749-4

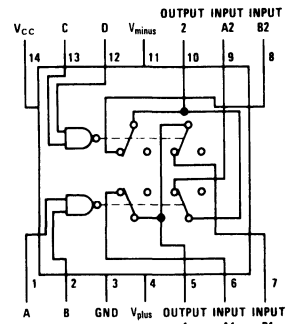


ANALOG INPUT A1 6
 ANALOG INPUT A2 8
 ANALOG INPUT B1 7
 ANALOG INPUT B2 8

ANALOG OUTPUT 1 5
 ANALOG OUTPUT 2 10

(b) AH0019

TL/H/8749-5



Note: All inputs "HIGH"

TL/H/8749-6

FIGURE 2. AH0014 and AH0019 DTL-TTL Compatible MOS Analog Switches

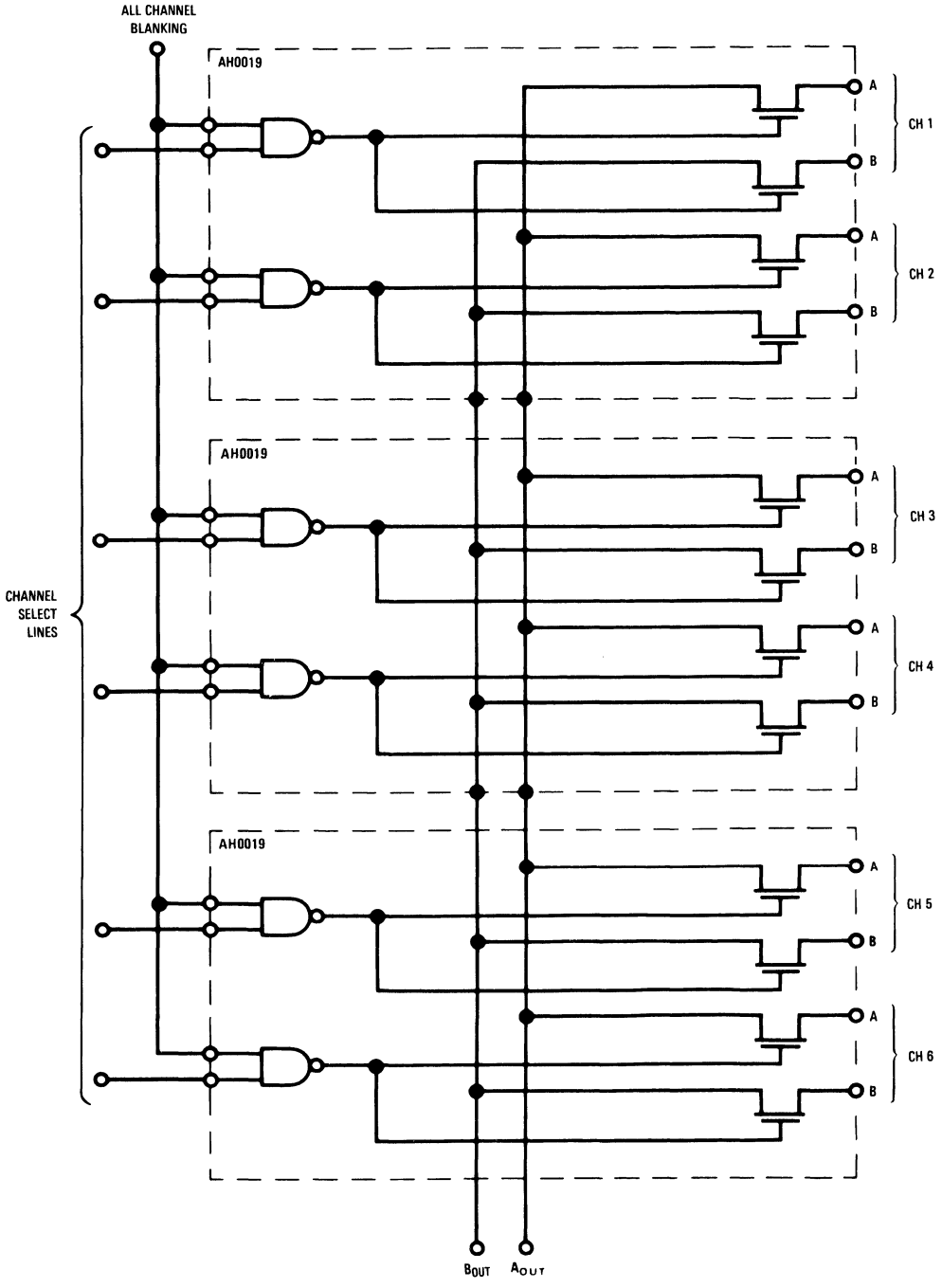


FIGURE 3. Differential Signal Commutator—AH0019

TL/H/8749-7

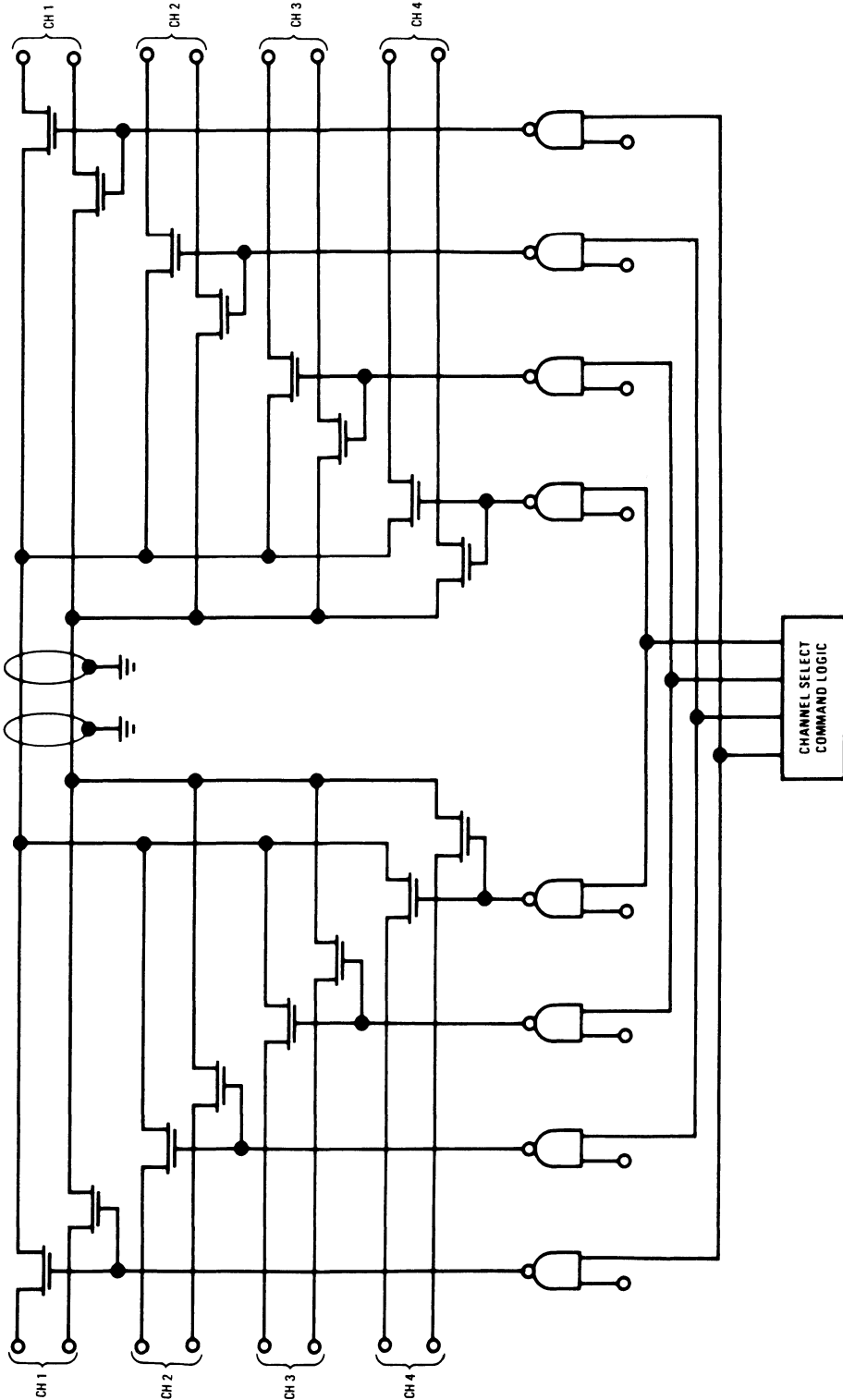


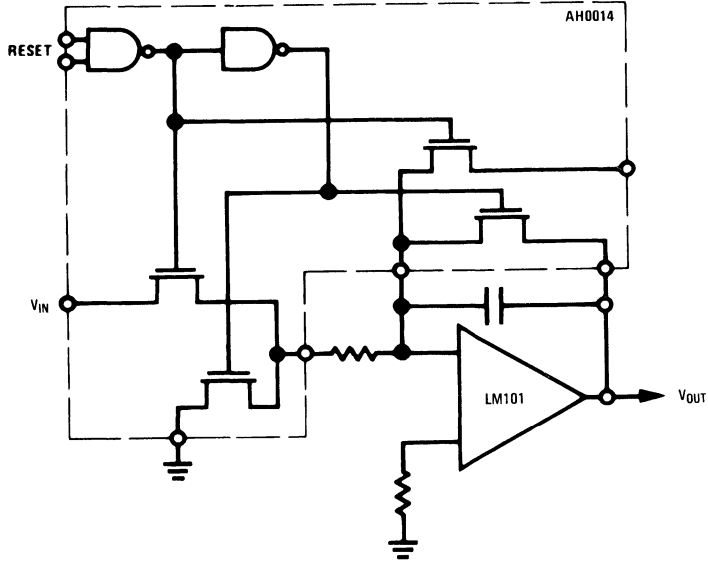
FIGURE 4. Commutation-Modulation and Demodulation

USAGE IN LINEAR AMPLIFIER CIRCUITS

The AH0014 and AH0019 devices are useful for switching functions in linear circuit applications because of high off/on resistance ratio and ease of switching control using logic elements. Sample and hold circuits, integrator reset switching, and reset stabilized amplifiers are a few examples (Fig-

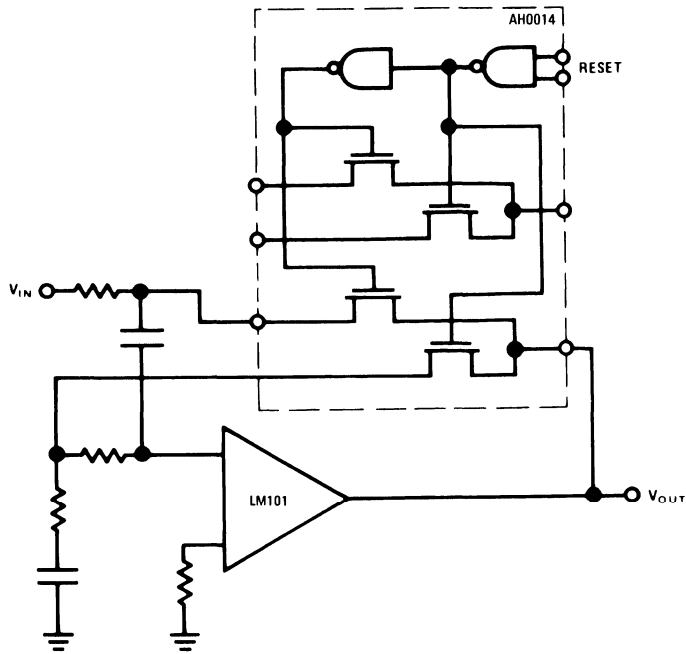
ure 5). More detailed information on this type of circuitry is available in National Semiconductor applications notes AN-4, AN-5, AN-20, and AN-294-7.

An obvious use of the AH0014 and AH0019 are in chopper stabilized amplifiers (Figure 6). One of the better forms of chopper stabilized amplifiers is the series shunt chopper



(a) Integrator

TL/H/8749-9



(b) Reset Stabilized Amplifier

TL/H/8749-10

FIGURE 5. Switching Applications with Linear Circuits

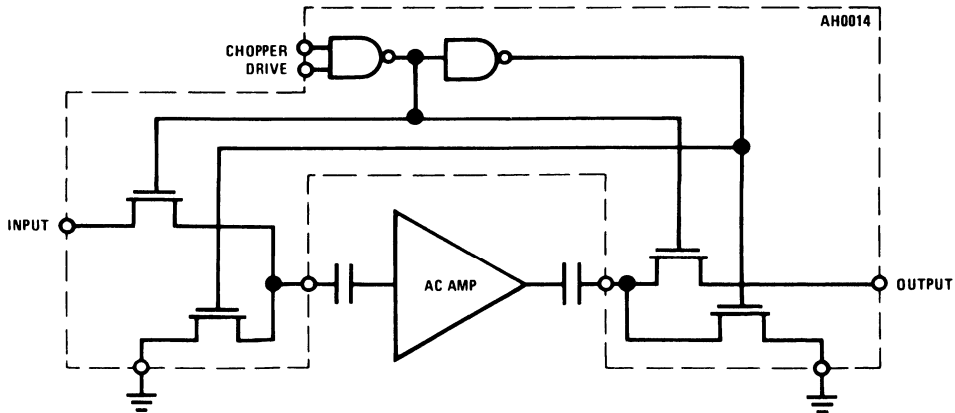


FIGURE 6. Series-Shunt Chopper Stabilized Amplifier

TL/H/8749-11

with sample and hold type of output. The AH0014 does a good job at this because it contains the complete set of switches plus proper drive for the switches. The AH0014 can greatly reduce component count for chopper stabilized amplifiers.

DOUBLE SIDEBAND MODULATOR

The AH0019 can be used as a double sideband modulator. In modulator applications, the AH0019 functions as a DPDT switch which alternately reverses the polarity of the modulating signal at the chopper frequency. MOS switches work quite well at this application because of zero offset voltage and large signal handling ability.

In order to build a double sideband balanced modulator^{8,9}, one of the two modulating inputs must be applied as a balanced input. For the circuit shown in *Figure 7*, an LM102 and LM107 were used for an audio phase splitter.

Both point A and point B in *Figure 7* are DSB modulated outputs; so, technically, you could get by with only one. The waveform at point A is illustrated in *Figure 8a* for a carrier frequency of 100 kHz and an audio frequency of 12.5 kHz. Point B is equal and out of phase.

One type of spurious response encountered with MOS switching devices is output spikes caused by a charge being dumped into the channel by the gated drive through gate-channel capacitance. By adding C1, part of the charge can be absorbed, thus reducing the voltage amplitude of the spikes. The R1C1 combination has its 3 dB point at about 80 kc, so output from the phase splitter was not attenuated in the audio range.

The astute observer will notice switching transients on the waveform in *Figure 8a*. By taking the output in differential form at points A and B, these transients are greatly reduced because the desired signals are equal but of opposite polarity, while the switching transients are an "in phase" or "common mode" error.

To better illustrate the improvement by using a balanced output, the audio signal was reduced to zero volts and the points A, B, and A-B were measured as shown in *Figure 9*. The improvement operating in the differential mode is obvious.

The circuit drive requirements for *Figure 7* may be simplified by using the AH0014 since it provides an inverting function internally. Only one phase of toggle drive to the AH0014 is required.

The modulation will be distorted more due to the phase lag created by the internal inverter of the AH0014. *Figure 10a* shows the switching performance of the AH0019 while *Figure 10b* shows the switching performance of the AH0014. In applications which do not require high carrier frequencies, the AH0014 is adequate, but for carrier frequencies above 100 kHz, the AH0019 provides improved performance because of its symmetrical switching behavior.

DOUBLE SIDEBAND DEMODULATOR

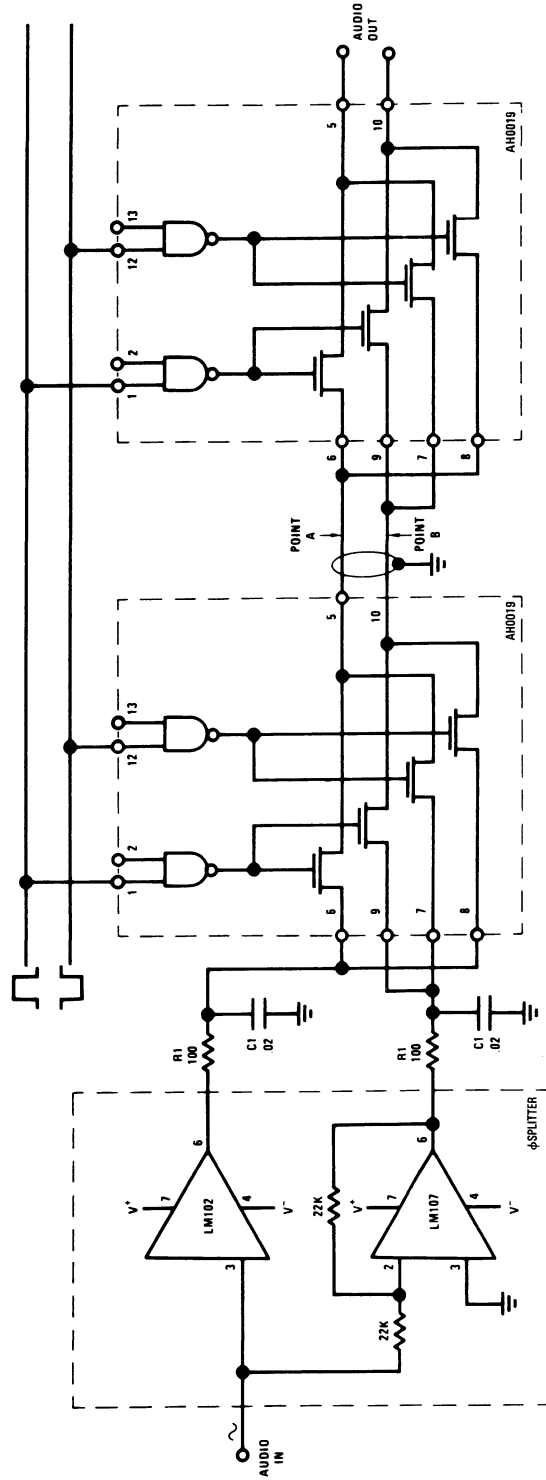
The major requirement of double sideband signal demodulation is proper carrier reinsertion. For maximum output, the carrier must be reinserted exactly in phase or exactly 180° out of phase with respect to the signal. Any departure from this optimum phase relationship will reduce the recovered signal amplitude. By applying the double sideband signal to a second AH0019 as shown in *Figure 7*, the original modulating waveform may be recovered, along with some switching transients (*Figure 11*).

These switching transients may be filtered out quite easily. It is, however, instructive to compare the recovered audio signal with the original. The modulating signal had less than 0.1% distortion at 1 kHz. *Figure 12* shows the distortion of the recovered signal vs. signal amplitude.

Carrier frequency was 100 Hz for the upper curve and 10 kHz for the lower. These curves indicate that most of the distortion is due to switching transients, especially at low modulation levels. Output filtering will significantly reduce the recovered signal distortion.

Figure 13 emphasizes the affect that switching transients have on harmonic distortion. At carrier frequencies below 10 kHz, the RMS value of the transients is reduced to a point where distortion of the MOS switches themselves can be seen.

The AH0014 and AH0019 data sheet suggests a V⁺ supply value of 10V and a V⁻ supply value of -20V. However, switching transients may be reduced by using different power supply voltages. *Figure 14* and *Figure 15* show what happens to harmonic distortion caused by spiking versus power supply level. *Figure 14* is plotted for V⁻ and V⁺ at 10V. *Figure 15* shows what happens as V⁺ is varied. All of the previous data was taken at V⁺ at 14V and V⁻ at -12V.



TL/H/8749-12

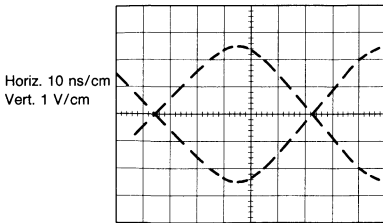
FIGURE 7. Double Sideband Modulator-Demodulator

AM-FM DEMODULATOR

Although an AM-FM demodulator was not physically constructed, the previously discussed "double sideband demodulator" performance implies that a very interesting phase detector can be built. The interesting features of this type of a detector are large dynamic range, recovery of both in-phase (amplitude modulated) and quadrature-phase (frequency modulated) signals plus the feasibility of not using any inductors for tuning.

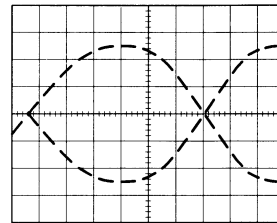
Figure 16 shows the proposed circuit block diagram which uses a phase-locked loop for phase reference signal. The

voltage controlled oscillator (VCO) is operated at $4 f_0$. Flip Flop # 1 provides a two phase output which is fed into FF #2 and FF #3. The outputs of FF #2 and FF #3 are exactly 90° out of phase regardless of the frequency of the VCO. This kind of performance is awfully hard to achieve using tuned circuits. For a 455 kHz detector, the VCO would operate at 1820 kHz. TTL flip flops will operate quite nicely at that frequency and should hold phase shift errors to practically zero. The LM107 provides DC gain to close the phase-locked loop, it forces the VCO to a frequency and phase angle which causes the "FM out" port to zero volts DC; this



TL/H/8749-13

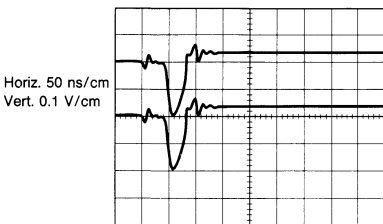
(a) V_a



TL/H/8749-14

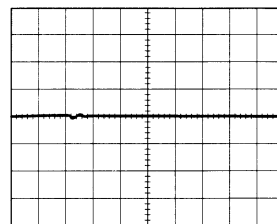
(b) $V_a - V_b$

FIGURE 8. Double Sideband Signal



TL/H/8749-15

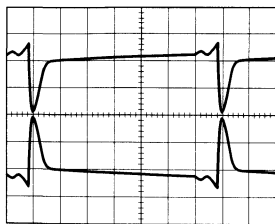
(a) Upper Trace— V_a
Lower Trace— V_b



TL/H/8749-16

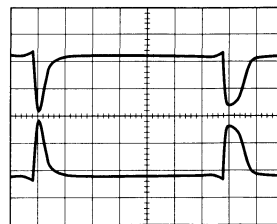
(b) $V_a - V_b$

FIGURE 9. MOS Switching Transients



TL/H/8749-17

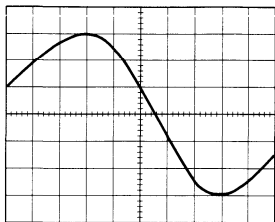
(a) NH0019 50 ns/cm



TL/H/8749-18

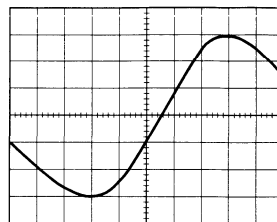
(b) NH0014 50 ns/cm

FIGURE 10. Channel Switching—AH0019 vs AH0014



TL/H/8749-19

(a) Single Ended Output



TL/H/8749-20

(b) Differential Output

FIGURE 11. Demodulator Recovered Output

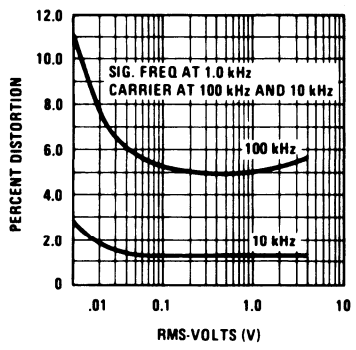


FIGURE 12. Recovered Signal Harmonic Distortion vs Audio Modulation Level

TL/H/8749-21

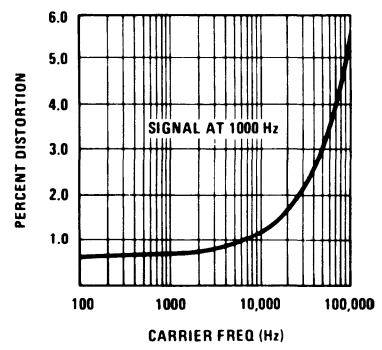


FIGURE 13. Recovered Signal Harmonic Distortion vs Carrier Frequency

TL/H/8749-22

There was little significant difference in distortion at signal amplitudes of 3.0V, 1.0V, 0.3V, 0.1 VRMS.

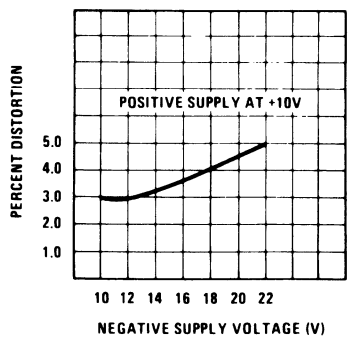


FIGURE 14. Harmonic Distortion vs Negative Power Supply Voltage

TL/H/8749-23

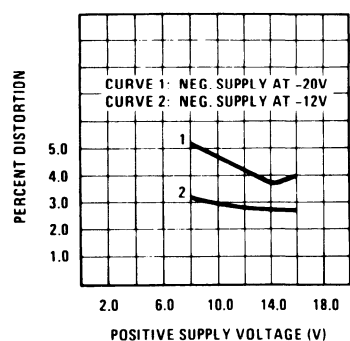


FIGURE 15. Harmonic Distortion vs Positive Supply Voltage

TL/H/8749-24

port is then operating exactly in quadrature with the applied signal. This part of the detector is then insensitive to amplitude modulation and sensitive to frequency modulation. Since the AM detector portion is operating exactly 90° out of phase with the FM portion, its output is insensitive to FM and sensitive to AM.

CONCLUSION

The most obvious use of the AH0014 and AH0019 is in commutator applications, and it indeed is a very useful device for that purpose. The use of these switches in linear circuit applications is also very attractive because of DTL-TTL control compatibility. There are many more uses

of these switches possible than the few examples described here.

The unusual application of these devices as suppressed carrier double-sideband modulators and demodulators suggests applications in servo systems and even communications systems due to their high speed operation. The final circuit suggestion, a phase-locked loop AM-FM demodulator without tuned circuits should be very useful in communications systems. The AH0019 will operate quite well at an IF frequency of 455 kHz or less.

These basic capabilities of the MOS dual differential switch should encourage much greater usage of this type of device in new product designs.

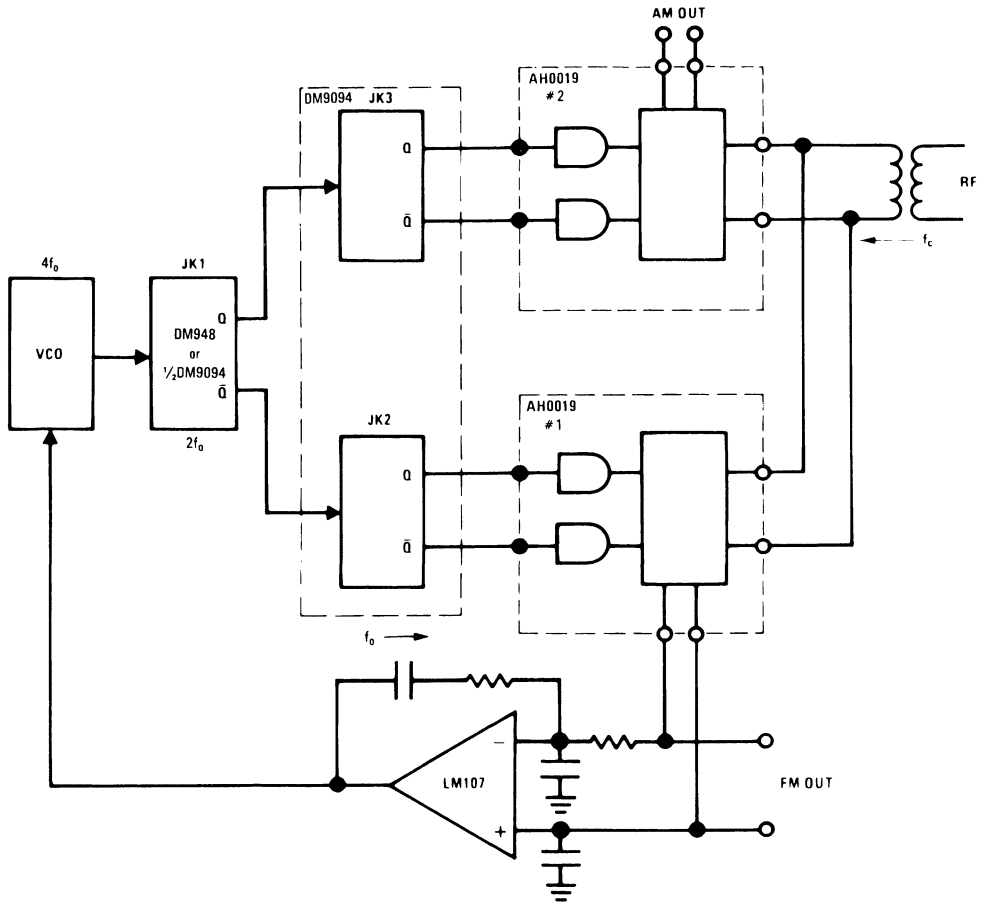


FIGURE 16. AM-FM Demodulator

TL/H/8749-25

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Precision IC Comparator Runs from +5V Logic Supply

National Semiconductor
Application Note 41



AN-41

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Introduction

In digital systems, it is sometimes necessary to convert low level analog signals into digital information. An example of this might be a detector for the illumination level of a photodiode. Another would be a zero crossing detector for a magnetic transducer such as a magnetometer or a shaft-position pickoff. These transducers have low-level outputs, with currents in the low microamperes or voltages in the low millivolts. Therefore, low level circuitry is required to condition these signals before they can drive logic circuits.

A voltage comparator can perform many of these precision functions. A comparator is essentially a high-gain op amp designed for open loop operation. The function of a comparator is to produce a logic "one" on the output with a positive signal between its two inputs or a logic "zero" with a negative signal between the inputs. Threshold detection is accomplished by putting a reference voltage on one input and the signal on the other. Clearly, an op amp can be used as a comparator, except that its response time is in the tens of microseconds which is often too slow for many applications.

A unique comparator design will be described here along with some of its applications in digital systems. Unlike older IC comparators or op amps, it will operate from the same 5V supply as DTL or TTL logic circuits. It will also operate with the single negative supply used with MOS logic. Hence, low level functions can be performed without the extra supply voltages previously required.

The versatility of the comparator along with the minimal circuit loading and considerable precision recommend it for many uses, in digital systems, other than the detection of low level signals. It can be used as an oscillator or multivibrator, in digital interface circuitry and even for low voltage analog circuitry. Some of these applications will also be discussed.

Circuit Description

In order to understand how to use this comparator, it is necessary to look briefly at the circuit configuration. *Figure 1* shows a simplified schematic of the device. PNP transistors

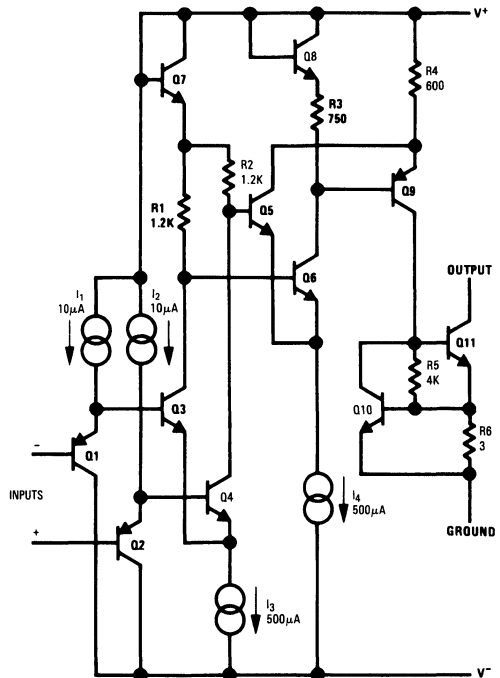


Figure 1. Simplified schematic of the comparator

buffer the differential input stage to get low input currents without sacrificing speed. The PNP's drive a standard NPN differential stage, Q₃ and Q₄. The output of this stage is further amplified by the Q₅—Q₆ pair. This feeds Q₉ which provides additional gain and drives the output stage. Current sources are used to determine the bias currents, so that performance is not greatly affected by supply voltages.

The output transistor is Q_{11} , and it is protected by Q_{10} and R_6 which limit the peak output current. The output lead, since it is not connected to any other point in the circuit, can either be returned to the positive supply through a pull-up resistor or switch loads that are connected to a voltage higher than the positive supply voltage. The circuit will operate from a single supply if the negative supply lead is connected to ground. However, if a negative supply is available, it can be used to increase the input common mode range.

Table I summarizes the performance of the comparator when operating from a 5V supply. The circuit will work with

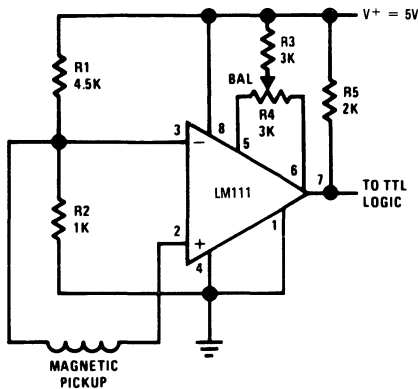
Table I. Important electrical characteristics of the LM111 comparator when operating from single, 5V supply ($T_A = 25^\circ\text{C}$)

Parameter	Limits			Units
	Min	Typ	Max	
Input Offset Voltage		0.7	3	mV
Input Offset Current		4	10	nA
Input Bias Current		60	100	nA
Voltage Gain		100		V/mV
Response Time		200		ns
Common Mode Range	0.3		3.8	V
Output Voltage Swing			50	V
Output Current			50	mA
Fan Out (DTL/TTL)			8	
Supply Current		3	5	mA

supply voltages up to $\pm 15\text{V}$ with a corresponding increase in the input voltage range. Other characteristics are essentially unchanged at the higher voltages.

low level applications

A circuit that will detect zero crossing in the output of a magnetic transducer within a fraction of a millivolt is shown in *Figure 2*. The magnetic pickup is connected between the two inputs of the comparator. The resistive divider, R_1 and R_2 , biases the inputs 0.5V above ground, within the com-

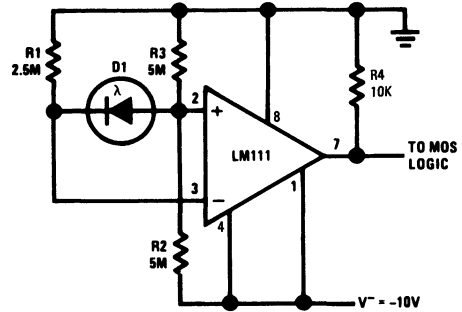


TL/H/7303-2

Figure 2. Zero crossing detector for magnetic transducer

mon mode range of the IC. The output will directly drive DTL or TTL. The exact value of the pull up resistor, R_5 , is determined by the speed required from the circuit since it must drive any capacitive loading for positive-going output signals. An optional offset-balancing circuit using R_3 and R_4 is included in the schematic.

Figure 3 shows a connection for operating with MOS logic. This is a level detector for a photodiode that operates off a -10V supply. The output changes state when the diode current reaches $1\ \mu\text{A}$. Even at this low current, the error contributed by the comparator is less than 1%.

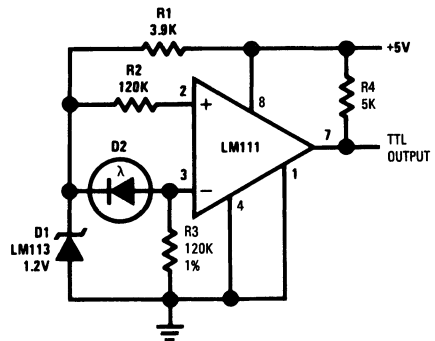


TL/H/7303-3

Figure 3. Level detector for photodiode

Higher threshold currents can be obtained by reducing R_1 , R_2 and R_3 proportionally. At the switching point, the voltage across the photodiode is nearly zero, so its leakage current does not cause an error. The output switches between ground and -10V , driving the data inputs of MOS logic directly.

The circuit in *Figure 3* can, of course, be adapted to work with a 5V supply. At any rate, the accuracy of the circuit will depend on the supply-voltage regulation, since the reference is derived from the supply. *Figure 4* shows a method



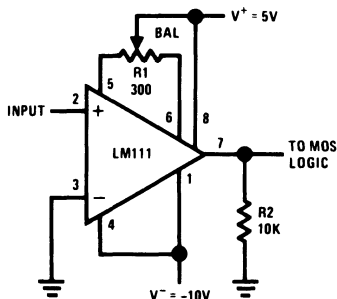
TL/H/7303-4

Figure 4. Precision level detector for photodiode

of making performance independent of supply voltage. D_1 is a temperature-compensated reference diode with a 1.23V breakdown voltage. It acts as a shunt regulator and delivers a stable voltage to the comparator. When the diode current is large enough (about $10\ \mu\text{A}$) to make the voltage drop

across R_3 equal to the breakdown voltage of D_1 , the output will change state. R_2 has been added to make the threshold error proportional to the offset current of the comparator, rather than the bias current. It can be eliminated if the bias current error is not considered significant.

A zero crossing detector that drives the data input of MOS logic is shown in *Figure 5*. Here, both a positive supply and



TL/H/7303-5

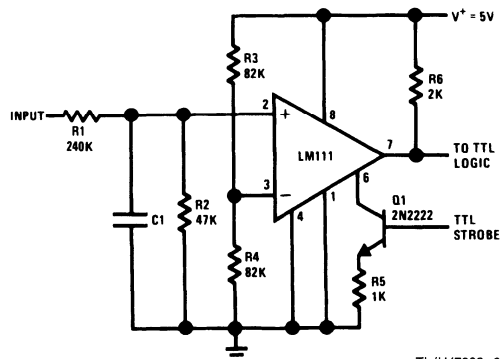
Figure 5. Zero crossing detector driving MOS logic

the -10V supply for MOS circuits are used. Both supplies are required for the circuit to work with zero common-mode voltage. An alternate balancing scheme is also shown in the schematic. It differs from the circuit in *Figure 2* in that it raises the input-stage current by a factor of three. This increases the rate at which the input voltage follows rapidly-changing signals from $7\text{V}/\mu\text{s}$ to $18\text{V}/\mu\text{s}$. This increased common-mode slew can be obtained without the balancing potentiometer by shorting both balance terminals to the positive-supply terminal. Increased input bias current is the price that must be paid for the faster operation.

digital interface circuits

Figure 6 shows an interface between high-level logic and DTL or TTL. The input signal, with 0V and 30V logic states is attenuated to 0V and 5V by R_1 and R_2 . R_3 and R_4 set up a 2.5V threshold level for the comparator so that it switches when the input goes through 15V . The response time of the circuit can be controlled with C_1 , if desired, to make it insensitive to fast noise spikes. Because of the low error currents of the LM111, it is possible to get input impedances even higher than the $300\text{ k}\Omega$ obtained with the indicated resistor values.

The comparator can be strobed, as shown in *Figure 6*, by the addition of Q_1 and R_5 . With a logic one on the base of Q_1 , approximately 2.5 mA is drawn out of the strobe terminal of the LM111, making the output high independent of the input signal.



TL/H/7303-6

Figure 6. Circuit for transmitting data between high-level logic and TTL

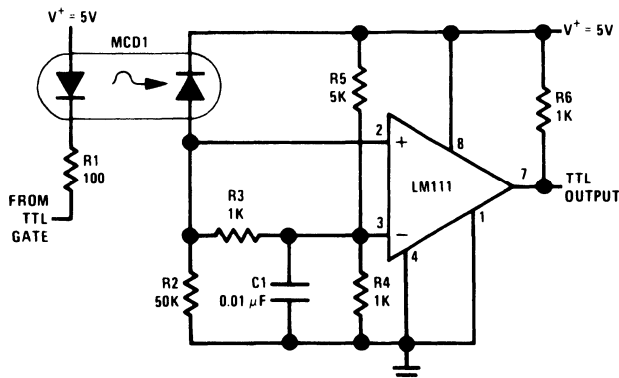
Sometimes it is necessary to transmit data between digital equipments, yet maintain a high degree of electrical isolation. Normally, this is done with a transformer. However, transformers have problems with low-duty-cycle pulses since they do not preserve the dc level.

The circuit in *Figure 7* is a more satisfactory method of obtaining isolation. At the transmitting end, a TTL gate drives a gallium-arsenide light-emitting diode. The light output is optically coupled to a silicon photodiode, and the comparator detects the photodiode output. The optical coupling makes possible electrical isolation in the thousands of megohms at potentials in the thousands of volts.

The maximum data rate of this circuit is 1 MHz . At lower rates ($\sim 200\text{ kHz}$) R_3 and C_1 can be eliminated.

multivibrators and oscillators

The free-running multivibrator in *Figure 8* is another example of the versatility of the comparator. The inputs are biased within the common mode range by R_1 and R_2 . DC stability, which insures starting, is provided by negative feedback through R_3 . The negative feedback is reduced at high frequencies by C_1 . At some frequency, the positive feedback through R_4 will be greater than the negative feedback; and the circuit will oscillate. For the component values

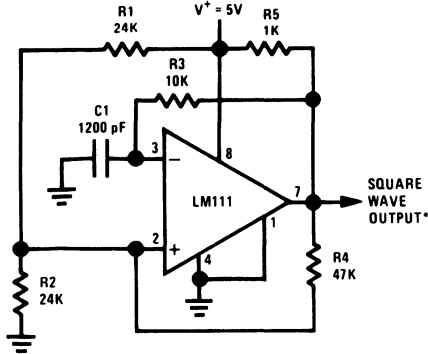


TL/H/7303-7

Figure 7. Data transmission system with near-infinite ground isolation

shown, the circuit delivers a 100 kHz square wave output. The frequency can be changed by varying C_1 or by adjusting R_1 through R_4 , while keeping their ratios constant.

Because of the low input current of the comparator, large circuit impedances can be used. Therefore, low frequencies can be obtained with relatively-small capacitor values: it is no problem to get down to 1 Hz using a 1 μ F capacitor. The speed of the comparator also permits operation at frequencies above 100 kHz.



TL/H/7303-8

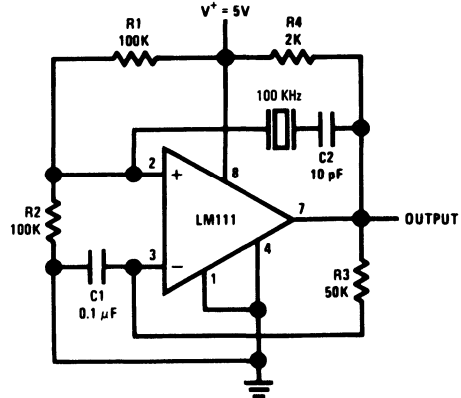
*TTL or DTL Fanout of two.

Figure 8. Free-running multivibrator

The frequency of oscillation depends almost entirely on the resistance and capacitor values because of the precision of the comparator. Further, the frequency changes by only 1% for a 10% change in supply voltage. Waveform symmetry is also good, but the symmetry can be varied by changing the ratio of R_1 to R_2 .

A crystal-controlled oscillator that can be used to generate the clock in slower digital systems is shown in *Figure 9*. It is similar to the free running multivibrator, except that the posi-

tive feedback is obtained through a quartz crystal. The circuit oscillates when transmission through the crystal is at a maximum, so the crystal operates in its series-resonant



TL/H/7303-9

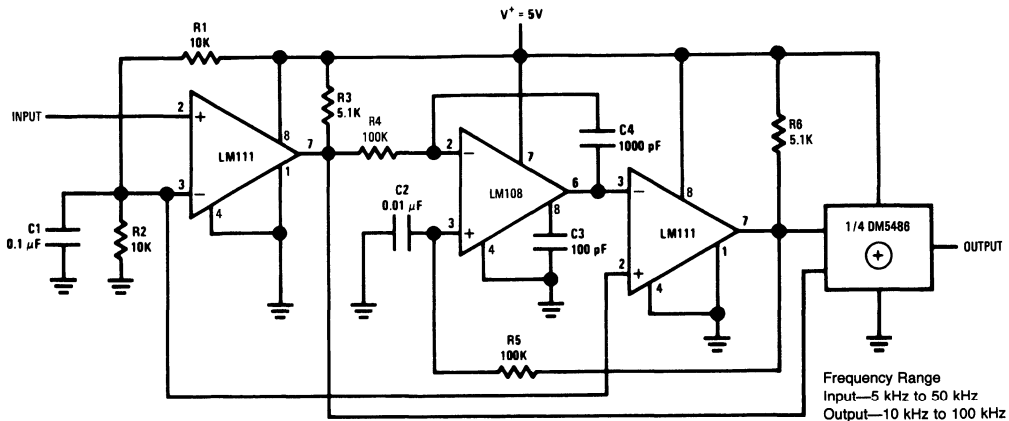
Figure 9. Crystal-controlled oscillator

mode. The high input impedance of the comparator and the isolating capacitor, C_2 , minimize loading of the crystal and contribute to frequency stability. As shown, the oscillator delivers a 100 kHz square-wave output.

frequency doubler

In a digital system, it is a relatively simple matter to divide by any integer. However, multiplying by an integer is quite another story especially if operation over a wide frequency range and waveform symmetry are required.

A frequency doubler that satisfies the above requirements is shown in *Figure 10*. A comparator is used to shape the in-

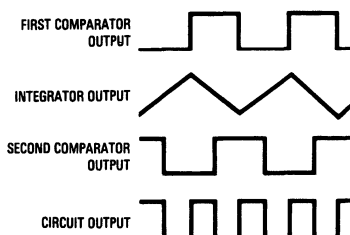


Frequency Range
Input—5 kHz to 50 kHz
Output—10 kHz to 100 kHz

TL/H/7303-10

Figure 10. Frequency doubler

put signal and feed it to an integrator. The shaping is required because the input to the integrator must swing between the supply voltage and ground to preserve symmetry in the output waveform. An LM108 op amp, that works from the 5V logic supply, serves as the integrator. This feeds a triangular waveform to a second comparator that detects when the waveform goes through a voltage equal to its average value. Hence, as shown in *Figure 11*, the output of the



TL/H/7303-11

Figure 11. Waveforms for the frequency doubler

second comparator is delayed by half the duration of the input pulse. The two comparator outputs can then be combined through an exclusive-OR gate to produce the double-frequency output.

With the component values shown, the circuit operates at frequencies from 5 kHz to 50 kHz. Lower frequency operation can be secured by increasing both C_1 and C_2 .

application hints

One of the problems encountered in using earlier IC comparators like the LM710 or LM106 was that they were prone to erratic operation caused by oscillations. This was a direct result of the high speed of the devices, which made it mandatory to provide good input-output isolation and low-inductance bypassing on the supplies. These oscillations could be particularly puzzling when they occurred internally, showing up at the external terminals only as erratic dc characteristics.

In general, the LM111 is less susceptible to spurious oscillations both because of its lower speed (200 ns response time vs 40 ns) and because of its better power supply rejection. Feedback between the output and the input is a lesser problem with a given source resistance. However, the LM111 can operate with source resistance that are orders of magnitude higher than the earlier devices, so stray coupling between the input and output should be minimized. With source resistances between 1 k Ω and 10 k Ω , the impedance (both capacitive and resistive) on both inputs should be made equal, as this tends to reject the signal fed back. Even so, it is difficult to completely eliminate oscillations in

the linear region with source resistances above 10 k Ω , because the 1 MHz open loop gain of the comparator is about 80 dB. However, this does not affect the dc characteristics and is not a problem unless the input signal dwells within 200 μ V of the transition level. But if the oscillation does cause difficulties, it can be eliminated with a small amount of positive feedback around the comparator to give a 1 mV hysteresis.

Stray coupling between the output and the balance terminals can also cause oscillations, so an attempt should be made to keep these leads apart. It is usually advisable to tie the balance pins together to minimize the effect of this feedback. If balancing is used, the same result can be accomplished by connecting a 0.1 μ F capacitor between these pins.

Normally, individual supply bypasses on every device are unnecessary, although long leads between the comparator and the bypass capacitors are definitely not recommended. If large current spikes are injected into the supplies in switching the output, bypass capacitors should be included at these points.

When driving the inputs from a low impedance source, a limiting resistor should be placed in series with the input lead to limit the peak current to something less than 100 mA. This is especially important when the inputs go outside a piece of equipment where they could accidentally be connected to high voltage sources. Low impedance sources do not cause a problem unless their output voltage exceeds the negative supply voltage. However, the supplies go to zero when they are turned off, so the isolation is usually needed.

Large capacitors on the input (greater than 0.1 μ F) should be treated as a low source impedance and isolated with a resistor. A charged capacitor can hold the inputs outside the supply voltage if the supplies are abruptly shut off.

Precautions should be taken to insure that the power supplies for this or any other IC never become reversed—even under transient conditions. With reverse voltages greater than 1V, the IC can conduct excessive current, fusing internal aluminum interconnects. This usually takes more than 0.5A. If there is a possibility of reversal, clamp diodes with an adequate peak current rating should be installed across the supply bus.

No attempt should be made to operate the circuit with the ground terminal at a voltage exceeding either supply voltage. Further, the 50V output-voltage rating applies to the potential between the output and the V^- terminal. Therefore, if the comparator is operated from a negative supply, the maximum output voltage must be reduced by an amount equal to the voltage on the V^- terminal.

The output circuitry is protected for shorts across the load. It will not, for example, withstand a short to a voltage more negative than the ground terminal. Additionally, with a sustained short, power dissipation can become excessive if the voltage across the output transistor exceeds about 10V.

The input terminals can exceed the positive supply voltage without causing damage. However, the 30V maximum rating between the inputs and the V^- terminal must be observed. As mentioned earlier, the inputs should not be driven more negative than the V^- terminal.

conclusions

A versatile voltage comparator that can perform many of the precision functions required in digital systems has been produced. Unlike older comparators, the IC can operate from the same supply voltage as the digital circuits. The comparator is particularly useful in circuits requiring considerable sensitivity and accuracy, such as threshold detectors for low level sensors, data transmission circuits or stable oscillators and multivibrators.

The comparator can also be used in many analog systems. It operates from standard $\pm 15V$ op amp supplies, and its dc accuracy equals some of the best op amps. It is also an order of magnitude faster than op amps used as comparators.

The new comparator is considerably more flexible than older devices. Not only will it drive RTL, DTL and TTL logic; but also it can interface with MOS logic or deliver $\pm 15V$ to FET analog switches. The output can switch 50V, 50 mA loads, making it useful as a driver for relays, lamps or light-emitting diodes. Further, a unique output stage enables it to drive loads referred to either supply or to ground and provide ground isolation between the comparator inputs and the load.

The LM111 is a plug-in replacement for comparators like the LM710 and LM106 in applications where speed is not of prime concern. Compared to its predecessors in other respects, it has many improved electrical specifications, more design flexibility and fewer application problems.

IC Provides On-Card Regulation for Logic Circuits

National Semiconductor
Application Note 42



AN-42

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introduction

Because of the relatively high current requirements of digital systems, there are a number of problems associated with using one centrally-located regulator. Heavy power busses must be used to distribute the regulated voltage. With low voltages and currents of many amperes, voltage drops in connectors and conductors can cause an appreciable percentage change in the voltage delivered to the load. This is aggravated further with TTL logic, as it draws transient currents many times the steady-state current when it switches.

These problems have created a considerable interest in on-card regulation, that is, to provide local regulation for the subsystems of the computer. Rough preregulation can be used, and the power distributed without excessive concern for line drops. The local regulators then smooth out the voltage variations due to line drops and absorb transients.

A monolithic regulator is now available to perform this function. It is quite simple to use in that it requires no external components. The integrated circuit has three active leads—input, output and ground—and can be supplied in standard transistor power packages. Output currents in excess of 1A can be obtained. Further, no adjustments are required to set up the output voltage, and overload protection is provided that makes it virtually impossible to destroy the regulator. The simplicity of the regulator, coupled with low-cost fabrication and improved reliability of monolithic circuits, now makes on-card regulation quite attractive.

design concepts

A useful on-card regulator should include everything within one package—including the power-control element, or pass transistor. The author has previously advanced arguments against including the pass transistor in an integrated circuit regulator.¹ First, there are no standard multi-lead power packages. Second, integrated circuits necessarily have a lower maximum operating temperature because they contain low-level circuitry. This means that an IC regulator needs a more massive heat sink. Third, the gross variations in chip temperature due to dissipation in the pass transistors worsen load and line regulation. However, for a logic-card regulator, these arguments can be answered effectively.

For one, if the series pass transistor is put on the chip, the integrated circuit need only have three terminals. Hence, an ordinary transistor power package can be used. The practicality of this approach depends on eliminating the adjustments usually required to set up the output voltage and limiting current for the particular application, as external adjustments require extra pins. A new solid-state reference, to be described later, has sufficiently-tight manufacturing tolerances that output voltages do not always have to be individually trimmed. Further, thermal overload protection can protect an IC regulator for virtually any set of operating conditions, making current—limit adjustments unnecessary.

Thermal protection limits the maximum junction temperature and protects the regulator regardless of input voltage, type of overload or degree of heat sinking. With an external pass transistor, there is no convenient way to sense junction temperature so it is much more difficult to provide thermal limiting. Thermal protection is, in itself, a very good reason for putting the pass transistor on the chip.

When a regulator is protected by current limiting alone, it is necessary to limit the output current to a value substantially lower than is dictated by dissipation under normal operating conditions to prevent excessive heating when a fault occurs. Thermal limiting provides virtually absolute protection for any overload condition. Hence, the maximum output current under normal operating conditions can be increased. This tends to make up for the fact that an IC has a lower maximum junction temperature than discrete transistors.

Additionally, the 5V regulator works with relatively low voltage across the integrated circuit. Because of the low voltage, the internal circuitry can be operated at comparatively high currents without causing excessive dissipation. Both the low voltage and the larger internal currents permit higher junction temperatures. This can also reduce the heat sinking required—especially for commercial-temperature-range parts.

Lastly, the variations in chip temperature caused by dissipation in the pass transistor do not cause serious problems for a logic-card regulator. The tolerance in output voltage is

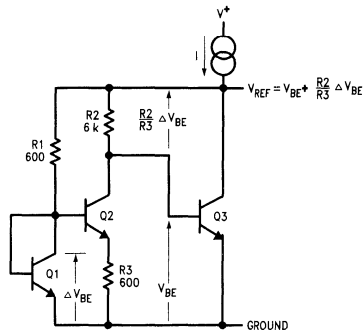
loose enough that it is relatively easy to design an internal reference that is much more stable than required, even for temperature variations as large as 150°C.

circuit description

The internal voltage reference for this logic-card regulator is probably the most significant departure from standard design techniques. Temperature-compensated zener diodes are normally used for the reference. However, these have breakdown voltages between 7V and 9V which puts a lower limit on the input voltage to the regulator. For low voltage operation, a different kind of reference is needed.

The reference in the LM109 does not use a zener diode. Instead, it is developed from the highly-predictable emitter-base voltage of the transistors. In its simplest form, the reference developed is equal to the energy-band-gap voltage of the semiconductor material. For silicon, this is 1.205V, so the reference need not impose minimum input voltage limitations on the regulator. An added advantage of this reference is that the output voltage is well determined in a production environment so that individual adjustment of the regulators is frequently unnecessary.

A simplified version of this reference is shown in *Figure 1*. In this circuit, Q₁ is operated at a relatively high current



TL/H/6931-1

Figure 1. The low voltage reference in one of its simpler forms.

density. The current density of Q₂ is about ten times lower, and the emitter-base voltage differential (ΔV_{BE}) between the two devices appears across R₃. If the transistors have high current gains, the voltage across R₂ will also be proportional to ΔV_{BE} . Q₃ is a gain stage that will regulate the output at a voltage equal to its emitter base voltage plus the drop across R₂. The emitter base voltage of Q₃ has a negative temperature coefficient while the ΔV_{BE} component

across R₂ has a positive temperature coefficient. It will be shown that the output voltage will be temperature compensated when the sum of the two voltages is equal to the energy-band-gap voltage.

Conditions for temperature compensation can be derived starting with the equation for the emitter-base voltage of a transistor which is²

$$V_{BE} = V_{g0} \left(1 - \frac{T}{T_0} \right) + V_{BE0} \left(\frac{T}{T_0} \right) + \frac{nkT}{q} \log_e \frac{T_0}{T} + \frac{kT}{q} \log_e \frac{I_C}{I_{C0}} \quad (1)$$

where V_{g0} is the extrapolated energy-band-gap voltage for the semiconductor material at absolute zero, q is the charge of an electron, n is a constant which depends on how the transistor is made (approximately 1.5 for double-diffused, NPN transistors), k is Boltzmann's constant, T is absolute temperature, I_C is collector current and V_{BE0} is the emitter-base voltage at T_0 and I_{C0} .

The emitter-base voltage differential between two transistors operated at different current densities is given by³

$$\Delta V_{BE} = \frac{kT}{q} \log_e \frac{J_1}{J_2} \quad (2)$$

where J is current density.

Referring to Equation (1), the last two terms are quite small and are made even smaller by making I_C vary as absolute temperature. At any rate, they can be ignored for now because they are of the same order as errors caused by non-theoretical behavior of the transistors that must be determined empirically.

If the reference is composed of V_{BE} plus a voltage proportional to ΔV_{BE} , the output voltage is obtained by adding (1) in its simplified form to (2):

$$V_{ref} = V_{g0} \left(1 - \frac{T}{T_0} \right) + V_{BE0} \left(\frac{T}{T_0} \right) + \frac{kT}{q} \log_e \frac{J_1}{J_2} \quad (3)$$

Differentiating with respect to temperature yields

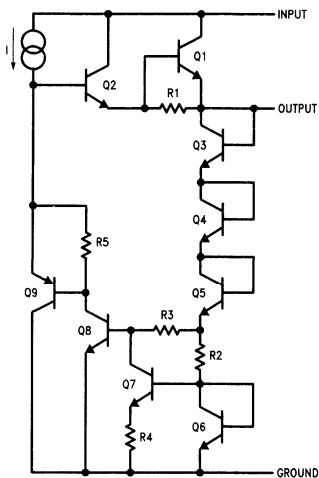
$$\frac{\partial V_{ref}}{\partial T} = -\frac{V_{g0}}{T_0} + \frac{V_{BE0}}{T_0} + \frac{k}{q} \log_e \frac{J_1}{J_2} \quad (4)$$

For zero temperature drift, this quantity should equal zero, giving

$$V_{g0} = V_{BE0} + \frac{kT_0}{q} \log_e \frac{J_1}{J_2} \quad (5)$$

The first term on the right is the initial emitter-base voltage while the second is the component proportional to emitter-base voltage differential. Hence, if the sum of the two are equal to the energy-band-gap voltage of the semiconductor, the reference will be temperature-compensated.

A simplified schematic for a 5V regulator is given in *Figure 2*. The circuitry produces an output voltage that is approximately four times the basic reference voltage. The emitter-base voltage of Q₃, Q₄, Q₅ and Q₈ provide the negative-temperature-coefficient component of the output voltage. The voltage dropped across R₃ provides the positive-temperature-coefficient component. Q₆ is operated at a considerably higher current density than Q₇, producing a voltage drop across R₄ that is proportional to the emitter-base voltage differential of the two transistors. Assuming large current gain in the transistors, the voltage drop across R₃ will be proportional to this differential, so a temperature-compensated-output voltage can be obtained.



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Figure 2. Schematic showing essential details of the 5V regulator.

In this circuit, Q₈ is the gain stage providing regulation. Its effective gain is increased by using a vertical PNP, Q₉, as a buffer driving the active collector load represented by the current source. Q₉ drives a modified Darlington output stage (Q₁ and Q₂) which acts as the series pass element. With this circuit, the minimum input voltage is not limited by the voltage needed to supply the reference. Instead, it is determined by the output voltage and the saturation voltage of the Darlington output stage.

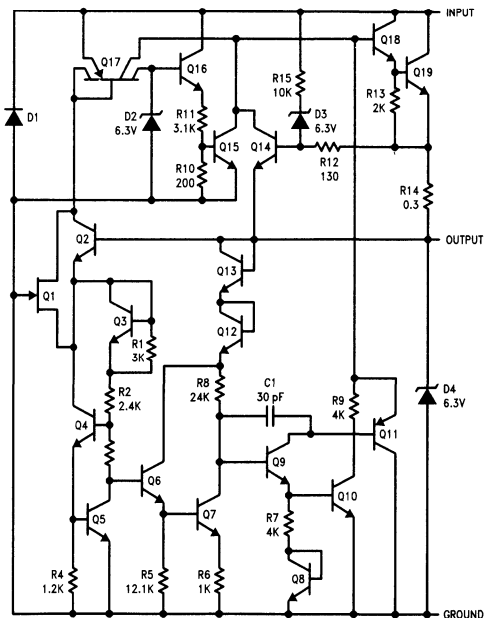
Figure 3 shows a complete schematic of the LM109, 5V regulator. The ΔV_{BE} component of the output voltage is developed across R₈ by the collector current of Q₇. The emitter-base voltage differential is produced by operating Q₄ and Q₅ at high current densities while operating Q₆ and Q₇ at much lower current levels. The extra transistors improve tolerances by making the emitter-base voltage differential larger. R₃ serves to compensate the transconductance⁴ of

Q₅, so that the ΔV_{BE} component is not affected by changes in the regular output voltage or the absolute value of components.

The voltage gain for the regulating loop is provided by Q₁₀, with Q₉ buffering its input and Q₁₁ its output. The emitter base voltage of Q₉ and Q₁₀ is added to that of Q₁₂ and Q₁₃ and the drop across R₈ to give a temperature-compensated, 5V output. An emitter-base-junction capacitor, C₁, frequency compensates the circuit so that it is stable even without a bypass capacitor on the output.

The active collector load for the error amplifier is Q₁₇. It is a multiple-collector lateral PNP⁴. The output current is essentially equal to the collector current of Q₂, with current being supplied to the zener diode controlling the thermal shutdown, D₂, by an auxiliary collector. Q₁ is a collector FET⁴ that, along with R₁, insures starting of the regulator under worst-case conditions.

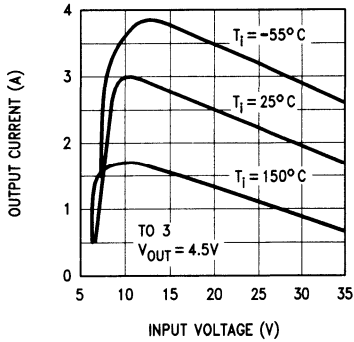
The output current of the regulator is limited when the voltage across R₁₄ becomes large enough to turn on Q₁₄. This insures that the output current cannot get high enough to cause the pass transistor to go into secondary breakdown or damage the aluminum conductors on the chip. Further, when the voltage across the pass transistor exceeds 7V, current through R₁₅ and D₃ reduces the limiting current,



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Figure 3. Detailed schematic of the regulator.

again to minimize the chance of secondary breakdown. The performance of this protection circuitry is illustrated in Figure 4.



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Figure 4. Current-limiting characteristics.

Even though the current is limited, excessive dissipation can cause the chip to overheat. In fact, the dominant failure mechanism of solid state regulators is excessive heating of the semiconductors, particularly the pass transistor. Thermal protection attacks the problem directly by putting a temperature regulator on the IC chip. Normally, this regulator is biased below its activation threshold; so it does not affect circuit operation. However, if the chip approaches its maximum operating temperature, for any reason, the temperature regulator turns on and reduces internal dissipation to prevent any further increase in chip temperature.

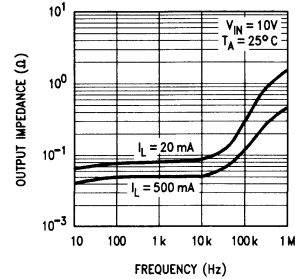
The thermal protection circuitry develops its reference voltage with a conventional zener diode, D_2 . Q_{16} is a buffer that feeds a voltage divider, delivering about 300 mV to the base of Q_{15} at 175°C. The emitter-base voltage, Q_{15} , is the actual temperature sensor because, with a constant voltage applied across the junction, the collector current rises rapidly with increasing temperature.

Although some form of thermal protection can be incorporated in a discrete regulator, IC's have a distinct advantage: the temperature sensing device detects increases in junction temperature within milliseconds. Schemes that sense case or heat-sink temperature take several seconds, or longer. With the longer response times, the pass transistor usually blows out before thermal limiting comes into effect.

Another protective feature of the regulator is the crowbar clamp on the output. If the output voltage tries to rise for some reason, D_4 will break down and limit the voltage to a safe value. If this rise is caused by failure of the pass transistor such that the current is not limited, the aluminum conductors on the chip will fuse, disconnecting the load. Although this destroys the regulator, it does protect the load from damage. The regulator is also designed so that it is not damaged in the event the unregulated input is shorted to

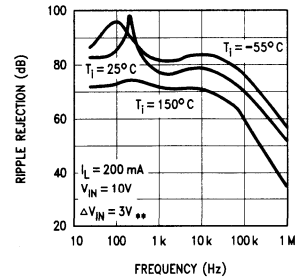
ground when there is a large capacitor on the output. Further, if the input voltage tries to reverse, D_1 will clamp this for currents up to 1A.

The internal frequency compensation of the regulator permits it to operate with or without a bypass capacitor on the output. However, an output capacitor does improve the transient response and reduce the high frequency output impedance. A plot of the output impedance in Figure 5 shows that it remains low out to 10 kHz even without a capacitor. The ripple rejection also remains high out to 10 kHz, as shown in Figure 6. The irregularities in this curve around 100 Hz are caused by thermal feedback from the pass transistor to the reference circuitry. Although an output capacitor is not required, it is necessary to bypass the input of the regulator with at least a 0.22 μ F capacitor to prevent oscillations under all conditions.



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Figure 5. Plot of output impedance as a function of frequency.

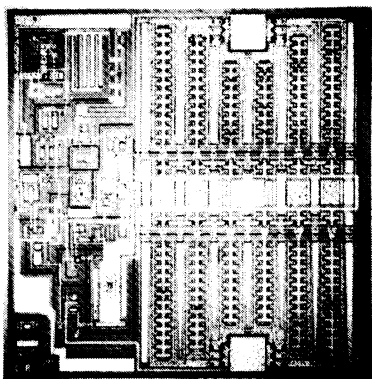


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Figure 6. Ripple rejection of the regulator.

Figure 7 is a photomicrograph of the regulator chip. It can be seen that the pass transistors, which must handle more than 1A, occupy most of the chip area. The output transistor is actually broken into segments. Uniform current distribution is insured by also breaking the current limit resistor into

segments and using them to equalize the currents. The overall electrical performance of this IC is summarized in Table I.



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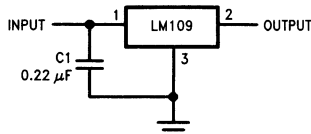
Figure 7. Photomicrograph of the regulator shows that high current pass transistor (right) takes more area than control circuitry (left).

TABLE I. Typical Characteristics of the Logic-Card Regulator: $T_A = 25^\circ\text{C}$

Parameter	Conditions	Typ
Output Voltage		5.0V
Output Current		1.5A
Output Resistance		0.03 Ω
Line Regulation	$7.0\text{V} \leq V_{IN} \leq 35\text{V}$	0.005%/V
Temperature Drift	$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$	0.02%/°C
Minimum Input Voltage	$I_{OUT} = 1\text{A}$	6.5V
Output Noise Voltage	$10\text{ Hz} \leq f \leq 100\text{ kHz}$	40 μV
Thermal Resistance Junction to Case	LM109H (TO-5) LM109K (TO-3)	15°C/W 3°C/W

applications

Because it was designed for virtually foolproof operation and because it has a singular purpose, the LM109 does not require a lot of application information, as do most other linear circuits. Only one precaution must be observed: it is necessary to bypass the unregulated supply with a 0.22 μF capacitor, as shown in Figure 8, to prevent oscillations that



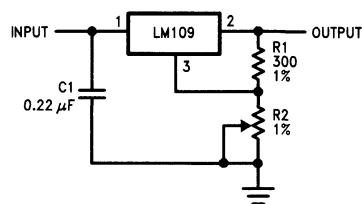
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Figure 8. Fixed 5V regulator.

can cause erratic operation. This, of course, is only necessary if the regulator is located on appreciable distance from the filter capacitors on the output of the dc supply.

Although the LM109 is designed as a fixed 5V regulator, it is also possible to use it as an adjustable regulator for higher

output voltages. One circuit for doing this is shown in Figure 9.

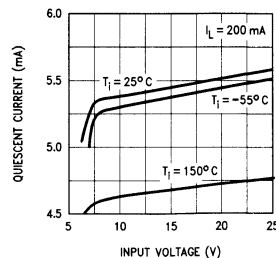


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Figure 9. Using the LM109 as an adjustable-output regulator.

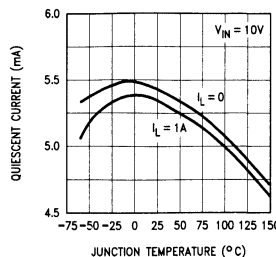
The regulated output voltage is impressed across R_1 , developing a reference current. The quiescent current of the regulator, coming out of the ground terminal, is added to this. These combined currents produce a voltage drop across R_2 which raises the output voltage. Hence, any voltage above 5V can be obtained as long as the voltage across the integrated circuit is kept within ratings.

The LM109 was designed so that its quiescent current is not greatly affected by variations in input voltage, load or temperature. However, it is not completely insensitive, as shown in Figures 10 and 11, so the changes do affect regulation somewhat. This tendency is minimized by making the reference current through R_1 larger than the quiescent current. Even so, it is difficult to get the regulation tighter than a couple percent.



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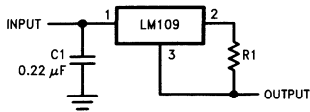
Figure 10. Variation of quiescent current with input voltage at various temperatures.



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Figure 11. Variation of quiescent current with temperature for various load currents.

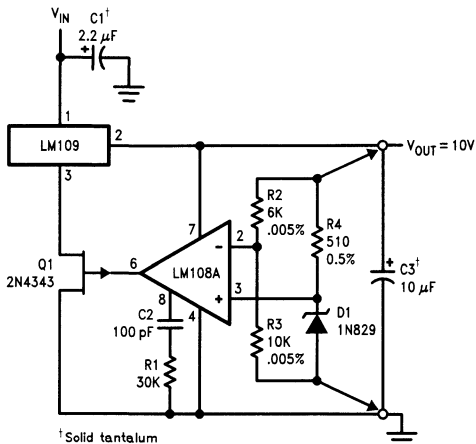
The LM109 can also be used as a current regulator as is shown in Figure 12. The regulated output voltage is impressed across R_1 , which determines the output current. The quiescent current is added to the current through R_1 , and this puts a lower limit of about 10 mA on the available output current.



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Figure 12. Current regulator.

The increased failure resistance brought about by thermal overload protection make the LM109 attractive as the pass transistor in other regulator circuits. A precision regulator that employs the IC thusly is shown in Figure 13. An operational amplifier compares the output voltage with the output voltage of a reference zener. The op amp controls the LM109 by driving the ground terminal through an FET.



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Figure 13. High stability regulator.

The load and line regulation of this circuit is better than 0.001%. Noise, drift and long term stability are determined

by the reference zener, D_1 . Noise can be reduced by inserting 100 k Ω , 1% resistors in series with both inputs of the op amp and bypassing the non-inverting input to ground. A 100 pF capacitor should also be included between the output and the inverting input to prevent frequency instability. Temperature drift can be reduced by adjusting R_4 , which determines the zener current, for minimum drift. For best performance, remote sensing directly to the load terminals, as shown in the diagram, should be used.

conclusions

The LM109 performs a complete regulation function on a single silicon chip, requiring no external components. It makes use of some unique advantages of monolithic construction to achieve performance advantages that cannot be obtained in discrete-component circuits. Further, the low cost of the device suggests its use in applications where single-point regulation could not be justified previously.

Thermal overload protection significantly improves the reliability of an IC regulator. It even protects the regulator for unforeseen fault conditions that may occur in field operation. Although this can be accomplished easily in a monolithic regulator, it is usually not completely effective in a discrete or hybrid device.

The internal reference developed for the LM109 also advances the state of the art for regulators. Not only does it provide a low voltage, temperature-compensated reference for the first time, but also it can be expected to have better long term stability than conventional zeners. Noise is inherently much lower, and it can be manufactured to tighter tolerances.

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The Phase Locked Loop IC as a Communication System Building Block

National Semiconductor
Application Note 46
Thomas B. Mills



INTRODUCTION

The phase locked loop has been found to be a useful element in many types of communication systems. It is used in two fundamentally different ways: (1) as a demodulator, where it is used to follow phase or frequency modulation and (2) to track a carrier or synchronizing signal which may vary in frequency with time.

When operating as a demodulator, the phase locked loop may be thought of as a matched filter operating as a coherent detector. When used to track a carrier, it may be thought of as a narrow-band filter for removing noise from a signal.

Recently, a phase locked loop has been built on a monolithic integrated circuit, incorporating the basic elements necessary for operation: a double balanced phase detector and a highly linear voltage controlled oscillator, the frequency of which can be varied with either a resistor or capacitor.

BASIC PHASE LOCK LOOP OPERATION

Figure 1 shows the basic blocks of a phase locked loop. The input signal e_i is a sinusoid of arbitrary frequency, while the VCO output signal, e_o , is a sinusoid of the same frequency as the input but of arbitrary phase. If

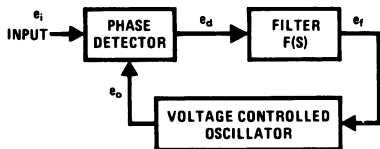
$$e_i = \sqrt{2} E_i \sin [\omega_o t + \theta_1(t)] \quad (1)$$

$$e_o = \sqrt{2} E_o \cos [\omega_o t + \theta_2(t)] \quad (2)$$

the output of the multiplier (phase detector) is

$$\begin{aligned} e_d &= e_i \cdot e_o \\ &= 2E_i E_o \sin [\omega_o t + \theta_1(t)] \cdot \cos [\omega_o t + \theta_2(t)] \\ &= E_i E_o \sin [\theta_1(t) - \theta_2(t)] + E_i E_o \sin [2\omega_o t + \theta_1(t) + \theta_2(t)] \end{aligned} \quad (3)$$

the low pass filter of the loop removes the ac components of the multiplier output; the dc term is seen to be a function of the phase angle between the VCO and the input signal.



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FIGURE 1. Basic Phase Locked Loop

The output of the VCO is related to its input control voltage by

$$\dot{\theta}_2(t) = K_o \theta_f \quad (4)$$

for $\theta_f = 0$. Let $\dot{\theta}_2 = \omega\theta$, then

$$\theta_2(t) = \int \theta_f(t) dt \quad (5)$$

It can be seen that the action of the VCO is that of an integrator in the feedback loop when the phase locked loop is considered in servo theory.

A better understanding of the operation of the loop may be obtained by considering that initially, the loop is not in lock, but that the frequency of the input signal e_i and VCO e_o are very close in frequency. Under these conditions e_d will be a beat note, the frequency of which is equal to the frequency difference of e_o and e_i . This signal is also applied to the VCO input, since it is low enough to pass through the filter. The instantaneous frequency of the VCO is therefore changing and at some point in time, if the VCO frequency equals the input frequency, lock will result. At this instant, θ_f will assume a level sufficient to hold the VCO frequency in lock with the input frequency. If the tuning of the VCO is changed (such as by varying the value of the tuning capacitor) the frequency output of the VCO will attempt to change; however, this will result in an instantaneous change in phase angle between e_i and e_o , resulting in a change in the dc level of e_d which will act to maintain frequency lock; no average frequency change will result.

Similarly, if e_i changes frequency, an instantaneous change will result in a phase change between e_i and e_o and hence a dc level change in e_d . This level shift will change the frequency of the VCO to maintain lock.

The amount of phase error resulting from a given frequency shift can be found by knowing the "dc" loop gain of the system. Considering the phase detector to have a transfer function:

$$E_d = K_D (\theta_1 - \theta_2)$$

and the voltage controlled oscillator to have a transfer function:

$$\dot{\theta}_2 = K_o \theta_f \quad (6)$$

or taking the Laplace transform

$$\theta_2(s) = \frac{K_o \theta_f}{s} \quad (7)$$

the phase of the VCO output will be proportional to the integral of the control voltage.

Combining these equations:

$$\frac{\theta_2(s)}{\theta_1(s)} = \frac{K_o K_D F(s)}{s + K_o K_D F(s)} \quad (8)$$

$$\frac{\theta_1(s) - \theta_2(s)}{\theta_1(s)} = \frac{s}{s + K_o K_D F(s)} \quad (9)$$

Application of the final value theorem of Laplace transforms yields

$$\lim_{t \rightarrow \infty} \theta_1(s) - \theta_2(s) = \lim_{s \rightarrow 0} \frac{s^2 \theta_1(s)}{s + K_o K_D F(s)} \quad (10)$$

With a step change in phase of the input $\Delta\theta_1$, the Laplace transform of the input is

$$\theta_1(s) = \frac{\Delta\theta_1}{s} \text{ which gives } \theta_e(s) = \theta_1(s) - \theta_2(s)$$

$$\lim_{t \rightarrow \infty} \theta_e(t) = \lim_{s \rightarrow 0} \frac{s \Delta\theta_1}{s + K_o K_D F(s)} = 0 \quad (11)$$

the loop will eventually track out any change of input phase, and there will be no phase error in the steady state solution. If the input is a step in frequency, of magnitude $\Delta\omega$, the change in input phase will be a ramp:

$$\theta_1(s) = \Delta\omega/s^2$$

substitution of this value θ , into (10) results in

$$\lim_{t \rightarrow \infty} \theta_e(t) = \lim_{s \rightarrow 0} \frac{\Delta\omega}{s + K_o K_D F(s)} = \frac{\Delta\omega}{K_o K_D F(0)} \quad (12)$$

this result shows the resulting phase error is dependent on the magnitude of the frequency step and the "dc" loop gain $K_o K_D$, which is also called the velocity error coefficient K_v . It should be noted that the dimensions of $K_o K_D$ are 1/sec. This can also be seen by considering $K_D = \text{volts/radian}$, while $K_o = \text{radians/sec/volt}$. The product is

$$\frac{\text{volts}}{\text{radian}} \times \frac{\text{radians/sec}}{\text{volt}} = \frac{1}{\text{sec}}$$

this can be thought of as the "dc" loop gain. (Note that additional dc gain between the phase detector and the voltage controlled oscillator will increase the loop gain and hence reduce the steady state phase error resulting from a change in frequency of the input).

THE LOOP FILTER

In working with phase locked loops, it is necessary to consider not only the "dc" performance described above, but the "ac" or transient performance which is governed by the components of the loop filter placed between the phase detector and the voltage controlled oscillator. In fact, it is this loop filter that makes the phase locked loop so powerful: only a resistor and capacitor are all that is needed to produce an arbitrarily narrow bandwidth at any selected center frequency.

The simplest filter is a single capacitor, *Figure 2*, and is used for wide bandwidth applications, such as where wideband

data modulation must be followed. The transfer function of the filter is simply:

$$\frac{e_f}{e_d} = \frac{1}{1 + sR_1 C_1} \quad (13)$$

substitution into (8) results in

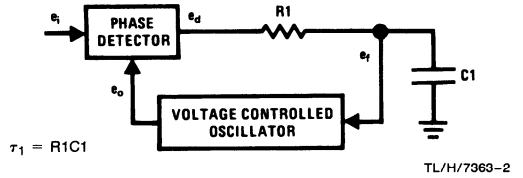
$$\frac{\theta_2(s)}{\theta_1(s)} = \frac{K_o K_D / \tau_1}{s^2 + s/\tau_1 + K_o K_D / \tau_1} \quad (14)$$

$$\tau_1 = R_1 C_1$$

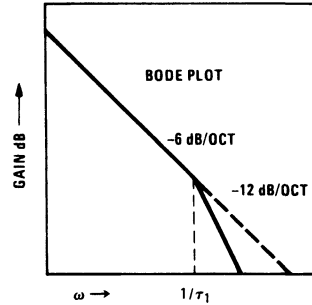
In terms of servo theory, the damping factor and natural frequencies are

$$\omega_n = \left[\frac{K_o K_D}{R_1 C_1} \right]^{1/2} \quad (15)$$

$$\zeta = \frac{1}{2} \left[\frac{1}{(R_1 C_1 K_o K_D)} \right]^{1/2} \quad (16)$$



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FIGURE 2. Phase Locked Loop with Simple Filter

From this it can be seen that large time constants for $R_1 C_1$ or high loop gain will reduce the damping factor and hence decrease stability. Therefore, if a narrow bandwidth is desired, the damping factor will become very small and instability will result. It is not possible to adjust bandwidth, loop gain, and damping independently with this simple filter.

With the addition of a damping resistor R_2 as shown in *Figure 3*, it is possible to choose bandwidth, damping factor and loop gain independently; the transfer function of this filter is

$$\frac{e_d}{e_f} = \frac{1 + s\tau_2}{1 + s\tau_1} \quad (17)$$

the loop transfer function becomes:

$$\frac{\theta_2(s)}{\theta_1(s)} = \frac{K_o K_D (s\tau_2 + 1)(\tau_1 + \tau_2)}{s^2 + s(1 + K_o K_D \tau_2)/\tau_1 + K_o K_D/\tau_1} \quad (18)$$

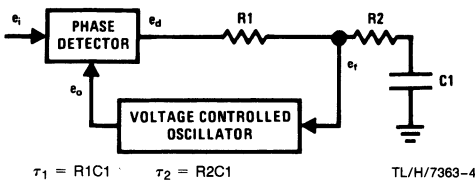
the loop natural frequency is

$$\omega_n = \left[\frac{K_o K_D}{\tau_1} \right]^{1/2} \quad (19)$$

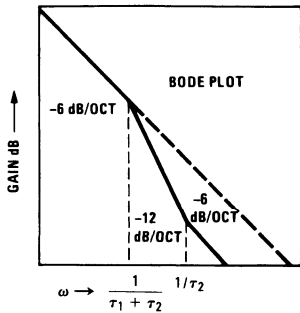
while the damping factor becomes

$$\zeta = \frac{1}{2} \left[\frac{1}{\tau_1 K_o K_D} \right]^{1/2} \left[1 + \tau_2 K_o K_D \right] \quad (20)$$

$$\approx \frac{\omega_n \tau_2}{2} \quad (21)$$



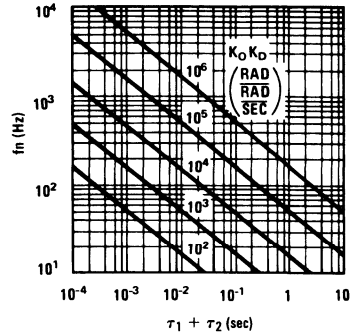
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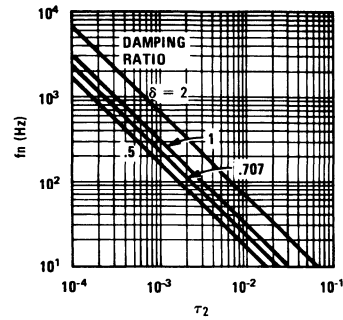
FIGURE 3. Phase Locked Loop with Damping Resistor Added

In practice, for a fixed loop gain $K_o K_D$, the natural frequency of the loop may be chosen and will be dependent mainly on τ_1 , since $\tau_2 \ll \tau_1$ in most cases. Then, according to (21), damping may be determined by τ_2 and for all practical purposes, will be an independent adjustment. These equations are plotted in *Figures 4* and *5* and may be used for design purposes.



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FIGURE 4. Filter Time Constant vs Natural Frequency



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FIGURE 5. Damping Time Constant vs Natural Frequency

DESIGN CONSIDERATIONS

Considering the above discussion, there are really two primary considerations in designing a phase locked loop. The use to which the loop is to be put will affect the design criterion of the loop components. The two primary factors to consider are:

1. Loop gain. As pointed out previously, this affects the phase error between the input signal and the voltage controlled oscillator for a given frequency shift of the input signal. It also determines the "hold in range" of the loop providing no components of the loop go into limiting or saturation. This is because the loop will remain in lock as long as the phase difference between the input and the VCO is less than $\pm 90^\circ$. The higher the loop gain, the further the input can change in frequency before the 90° phase error is reached. The hold in range is

$$\Delta\omega_H = \pm K_o K_D \quad (22)$$

(providing saturation or limiting does not occur).

2. Natural Frequency. The bandwidth of the loop is determined by the filter components R_1 , R_2 and C_1 , and the loop gain. Since the loop gain is normally selected by the criterion in 1. above, the filter components are used to select the bandwidth. The selection of loop bandwidth may be governed by several things: noise bandwidth, modulation rates if the loop is to be used as an FM de-

modulator, pull-in time and hold-in range. There are two conflicting requirements that will have an affect on loop bandwidth:

- (a) Loop bandwidth must be as narrow as possible to minimize output phase jitter due to external noise.
- (b) The loop bandwidth should be made as large as possible to minimize transient error due to signal modulation, output jitter due to internal oscillator (VCO) noise, and to obtain best tracking and acquisition properties.

These two principles are in direct opposition and, depending on what it is that the loop is to accomplish, an optimum solution will lie somewhere between the two extremes.

If the phase locked loop is to be used to demodulate frequency modulation, the design should proceed with the criterion of b above. It is necessary to provide sufficient loop bandwidth to accommodate the expected modulation. It must be remembered that at all times, the loop must remain in lock, (peak phase error less than 90°), even under extremes of modulation, such as peaks or step changes in frequency.

For the case of sinusoidal frequency modulation, the peak phase error as a function of frequency deviation and damping factor is shown in *Figure 6*.

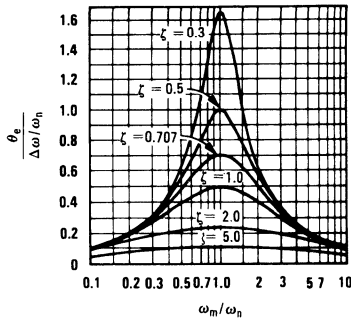


FIGURE 6. Steady-State Peak Phase Error Due to Sinusoidal FM (High-Gain, Second-Order Loop)

It can be seen that the maximum phase error occurs when the modulating frequency ω_m equals the loop natural frequency ω_n ; if the loop has been designed with a damping factor of 0.707, the peak phase error (in radians) will be 0.71 $\Delta\omega/\omega_n$ ($\Delta\omega$ = frequency deviation). From this plot, it is possible to choose ω_n for a given deviation and modulation frequency.

If the loop is to demodulate frequency shift keying (FSK), it must follow step changes in frequency. The filter components must then be chosen in accordance with the transient phase error shown in *Figure 7*. It must be remembered that the loop filter must be wide enough so the loop will not lose lock when a step change in frequency occurs: the greater the frequency step, the wider the loop filter must be to maintain lock.

There is some frequency-step limit below which the loop does not skip cycles, but remains in lock, called the "pull-out frequency" ω_{po} . Viterbi has analyzed this and his results are shown in *Figure 8*, which plots normalized pull out frequency for various damping factors for high gain second order loops. Peak phase errors for other types of input signals are shown in *Figures 8* and *9*.

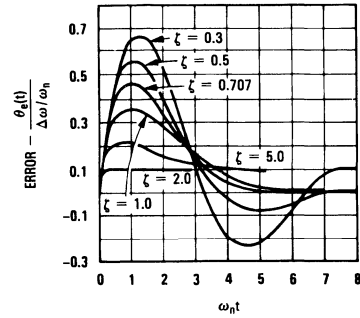


FIGURE 7. Transient Phase Error $\theta_e(t)$ Due to a Step in Frequency $\Delta\omega$. (Steady-State Velocity Error, $\Delta\omega/K_V$, Neglected)

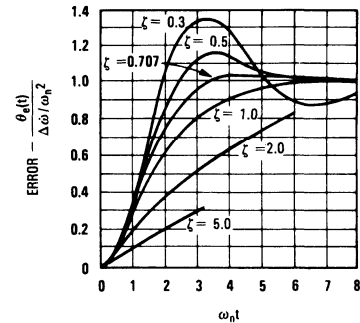


FIGURE 8. Transient Phase Error $\theta_e(t)$ Due to a Ramp in Frequency $\Delta\omega$. (Steady-State Acceleration Error, $\Delta\omega/\omega_n^2$, Included. Velocity Error, $\Delta\omega/K_V$, Neglected)

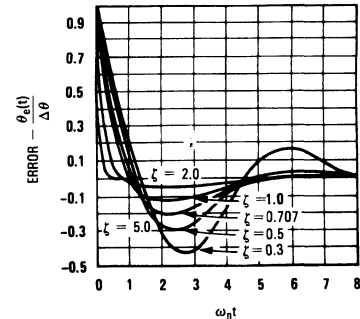


FIGURE 9. Phase Error $\theta_e(t)$ Due to a Step in Phase $\Delta\theta$

In designing loops to track a carrier or synchronizing signal, it is desirable to make the loop bandwidth narrow so that phase error due to external noise will be small. However, it is necessary to make the loop bandwidth wide enough so that any frequency jitter on the input signal will be followed.

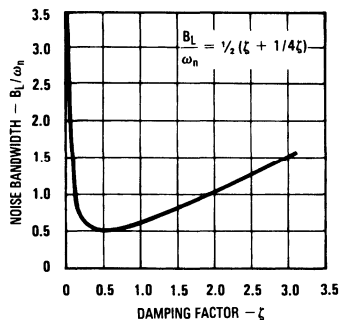
NOISE PERFORMANCE

Since one of the main uses of phase locked loops is to demodulate or track signals in noise, it is helpful to look at how noise affects the operation of the phase locked loop.

The phase locked loop, as mentioned earlier, may be thought of as a filter with a fixed, adjustable bandwidth. We have seen how to calculate the loop natural frequency ω_n (15), (19), and the damping factor ζ (16), (20). Without going through a derivation, the loop noise bandwidth B_L may be shown to be

$$B_L = \int_0^{\infty} |H(j\omega)|^2 d\omega = \frac{\omega_n}{2} \left[\zeta + \frac{1}{4\zeta} \right] \text{ Hz} \quad (23)$$

for a high gain, second order loop. This equation is plotted in *Figure 10*. It should be noted that the dimensions of noise bandwidth are cycles per second while the dimensions of ω_n are radians per second.

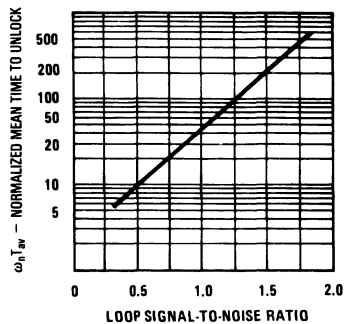


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FIGURE 10. Loop-Noise Bandwidth (For High-Gain, Second-Order Loop)

Noise threshold is a difficult thing to analyze in a phase locked loop, since we are talking about a statistical quantity. Noise will show up in the input signal as both amplitude and phase modulation. It can be shown that near optimum performance of a phase locked loop can be obtained if a limiter is used ahead of the phase detector, or if the phase detector is allowed to operate in limiting. With the use of a limiter, amplitude modulation of the input signal by noise is removed, and the noise appears as phase modulation. As the input signal to noise ratio decreases, the phase jitter of the input signal due to noise increases, and the probability of losing lock due to instantaneous phase excursions will increase. In practice it is nearly impossible to acquire lock if the signal to noise ratio in the loop $(\text{SNR})_L = 0$ dB. In general, $(\text{SNR})_L$ of +6 dB is needed for acquisition. If modulation or transient phase error is present, a higher signal to noise ratio is needed to acquire and hold lock.

A computer simulation performed by Sanneman and Rowbotham has shown the probability of skipping cycles for various loop signal to noise ratios for high gain, second order loops. Their data is shown in *Figure 11*.



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FIGURE 11. Unlock Behavior of High-Gain, Second-Order Loop, $\zeta = 0.707$

When designing the loop filter components, enough bandwidth in the loop must be allowed for instantaneous phase change due to input noise. In the previous section, the filter was selected on the basis that the peak error due to modulation would be less than 90° (so the loop would not lose lock). However, if noise is present, the peak phase error will increase due to the noise. So if the loop is not to lose lock on these noise peaks the peak allowable error due to modulation must be reduced to something less, on the order of 40° to 50° .

LOCKING

Initially, a loop is unlocked and the VCO is running at some frequency. If a signal is applied to the input, locking may or may not occur depending on several things.

If the signal is within the bandwidth of the loop filter, locking will occur without a beat note being generated or any cycles being skipped. This frequency is given by

$$\Delta\omega_L = \frac{K_0 K_D \tau_2}{\tau_1 + \tau_2} \approx 2\zeta \omega_n \quad (24)$$

If the frequency of the input signal is further away from the VCO frequency, locking may still occur, with a beat note being generated. The greatest frequency that can be pulled in is called the "pull in frequency" and is found from the approximation

$$\Delta\omega_P \approx \sqrt{2} \left(2\zeta \omega_n K_0 K_D - \omega_n^2 \right)^{1/2} \quad (25)$$

which works well for moderate and high gain loops ($\omega_n/K_0 K_D < 0.4$).

An approximate expression for pull in time (the time required to achieve lock from some frequency offset $\Delta\omega$) is given by:

$$T_P \approx \frac{(\Delta\omega)^2}{2\zeta \omega_n^3}$$

A MONOLITHIC PHASE LOCKED LOOP

A complete phase locked loop has been built on a monolithic integrated circuit. It features a very linear voltage controlled oscillator and a double balanced phase detector.

A simplified schematic of this voltage controlled oscillator is shown in *Figure 12*. Q_2 is a voltage controlled current source whose collector current is a linear function of the control voltage e_f . Initially Q_5 is OFF and the collector current of Q_2 passes through D_2 and charges C in a linear fashion. The voltage across C is therefore a ramp, and continues to increase until Q_7 is turned ON; this turns OFF Q_8 , causing Q_9 and Q_{11} to turn ON. This in turn turns ON Q_5 . With Q_5 ON, the anode of D_1 is clamped close to $-V_{CC}$ and D_2 stops conducting, since its cathode is more positive than its anode.

All of the current supplied by Q_2 is diverted through D_1 and Q_3 , which sets up an equal current in Q_4 . This current is supplied by the charged capacitor C (which now discharges linearly), causing the voltage across it to decrease. This continues until a lower trip point is reached and Q_7 turns OFF and the cycle repeats. Due to the matching of Q_3 and Q_4 , the charge current of C is equal to the discharge current and therefore the duty cycle is very nearly 50%. *Figure 13* shows the wave forms at (1) and (2).

Figure 14 shows the double balanced phase detector and amplifier used in the microcircuit. Transistors Q_1 through Q_4 are switched with the output of the VCO, while the input

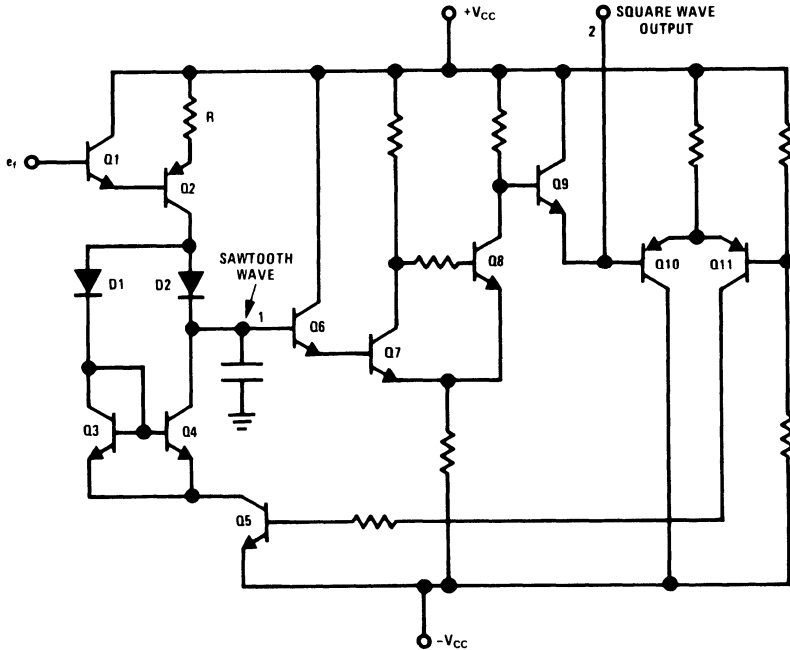


FIGURE 12. Simplified Voltage Controlled Oscillator

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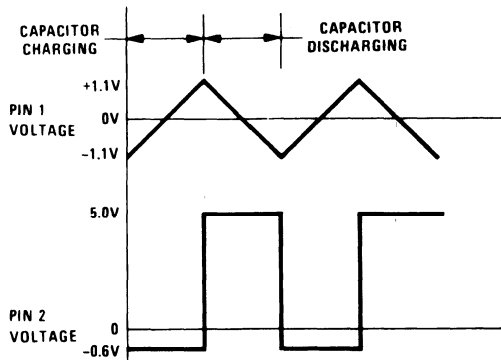


FIGURE 13. VCO Waveforms

TL/H/7363-15

signal is applied to the bases of Q_5 and Q_6 . The output current in resistors R_3 and R_4 is then proportional to the difference in phase between the VCO output and the input; the ac component of this current will be at twice the frequency of the VCO due to the full wave switching action transistors Q_1 through Q_4 . The waveforms of *Figure 15* illustrate how the phase detector works. Diodes D_1 and D_2 serve to limit the peak to peak amplitude of the collector voltage. The output of the phase detector is further amplified by Q_{10} and Q_{11} , and is taken as a voltage at pin 7.

R_8 serves as the resistive portion of the loop filter, and additional resistance and capacitance may be added here to fix the loop bandwidth. For use as an FM demodulator, the voltage at pin 7 will be the demodulated output; since the dc level here is fairly high, a reference voltage has been provided so that an operational amplifier with differential input can be used for additional gain and level shifting.

The complete microcircuit, called the LM565, is shown in *Figure 16*.

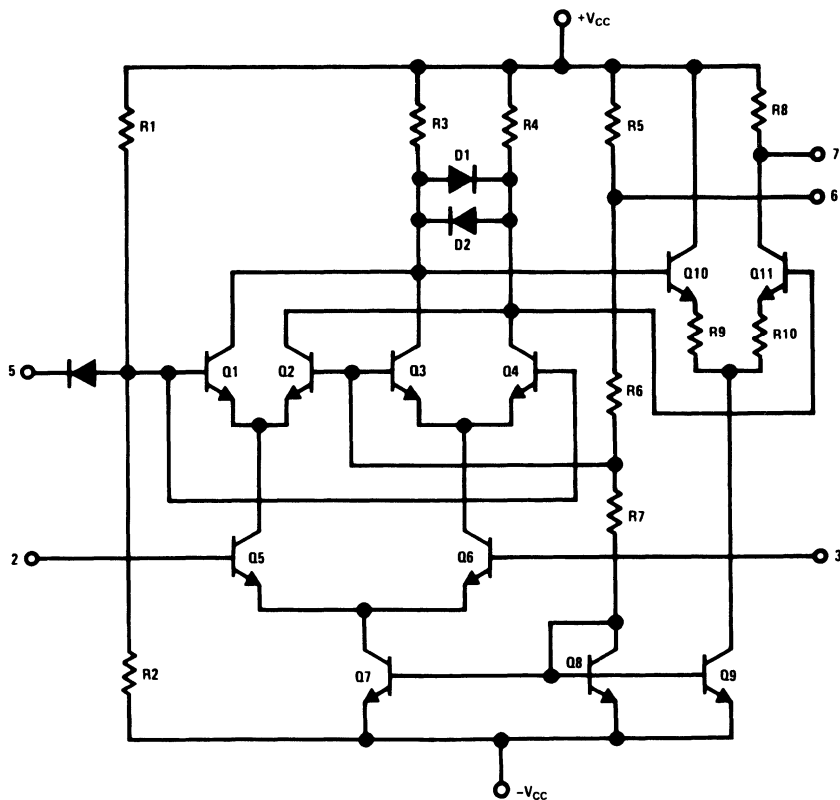


FIGURE 14. Phase Detector and Amplifier

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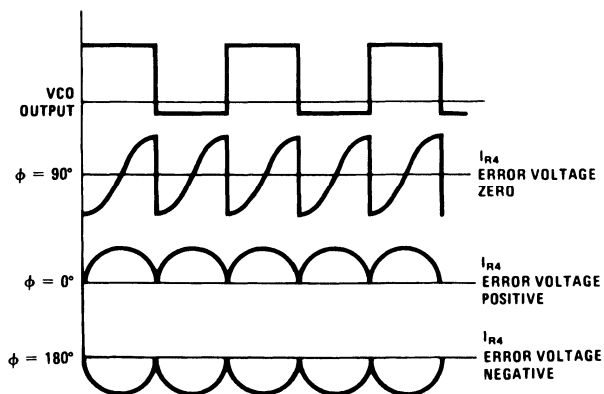
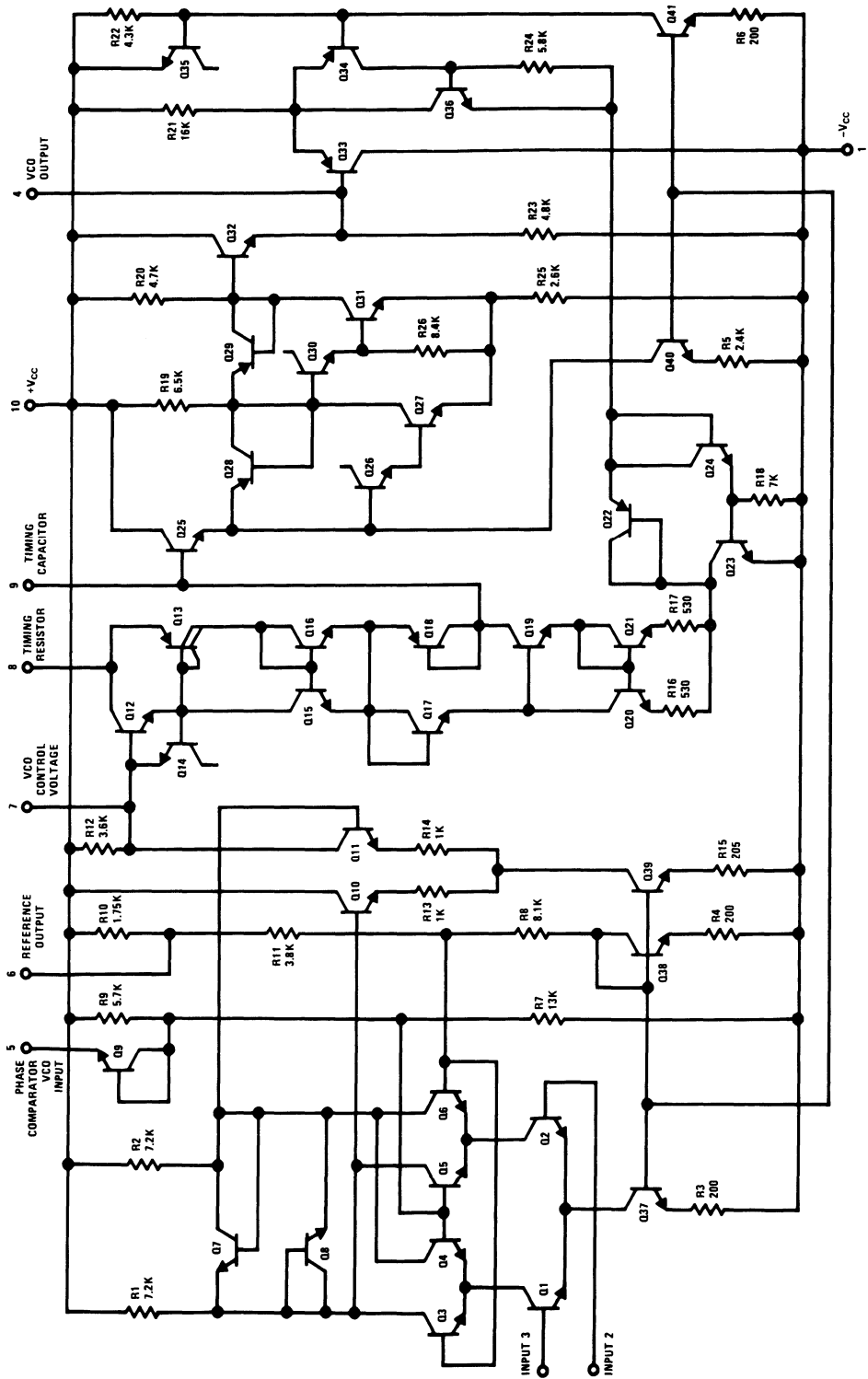


FIGURE 15. Phase Detector Waveforms, Showing Limit Cases for Phase Shift between Input and VCO Signals

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FIGURE 16. LM565 Phase Locked Loop

USING THE LM565

Some of the important operating characteristics of the LM565 are shown in the table below ($V_{CC} = \pm 6V$, $T_A = 25^\circ C$).

Phase Detector	
Input Impedance	5 k Ω
Input Level for Limiting	10 mV
Output Resistance	3.6 k Ω
Output Common Mode Voltage	4.5V
Offset Voltage (Between pins 6 and 7)	100 mV
Sensitivity K_D	.68V/rad
Voltage Controlled Oscillator	
Stability	
Temperature	200 ppm/ $^\circ C$
Supply Voltage	200 ppm/%
Square Wave Output Pin 4	5.4 V _{pp}
Triangle Wave Output Pin 9	2.4 V _{pp}
Maximum Operating Frequency	500 kHz
Sensitivity K_O	4.1 f_o rad/sec/V (f_o : osc. freq. in Hz)
Closed Loop Performance	
Loop Gain $K_O K_D$	2.8 f_o /sec
Demod. Output, $\pm 10\%$ Deviation (A 0.001 μF capacitor is needed between pins 7 and 8 to stop parasitic oscillations).	300 mV

To best illustrate how the LM565 is used, several applications are covered in detail, and should provide insight into the selection of external components for use with the LM565.

IRIG CHANNEL DEMODULATOR

In the field of missile telemetry, it is necessary to send many channels of relatively narrow band data via a radio link. It has been found convenient to frequency modulate this infor-

mation on a set of subcarriers with center frequencies in the range of 400 Hz to 200 kHz. Standardization of these frequencies was undertaken by the Inter-Range Instrumentation Group (IRIG) and has resulted in several sets of subcarrier channels, some based on deviations that are a fixed percentage of center frequency and other sets that have a constant deviation regardless of center frequency. IRIG channel 13 has been selected as an example to demonstrate the usefulness of the LM565 as an FM demodulator.

IRIG Channel	13
Center Frequency	14.5 kHz
Max Deviation	$\pm 7.5\%$
Frequency Response	220 Hz
Deviation Ratio	5

Since with a deviation of $\pm 10\%$, the LM565 will produce approximately 300 mV peak to peak output, with a deviation of 7.5% we can expect an output of 225 mV. It is desirable to amplify and level shift this signal to ground so that plus and minus output voltages can be obtained for frequency shifts above and below center frequency.

An LM107 can be used to provide the necessary additional gain and the level shift. In Figure 17, R_4 is used to set the output at zero volts with no input signal. The frequency of the VCO can be adjusted with R_3 to provide zero output voltage when an input signal is present.

The design of the filter network proceeds as follows:

It is necessary to choose ω_n such that the peak phase error in the loop is less than 90° for all conditions of modulation. Allowing for noise modulation at low levels of signal to noise, a desirable peak phase error might be 1 radian or 57 degrees, leaving a 33 degree margin for noise. Assuming sinusoidal modulation, Figure 6 can be used to estimate the peak normalized phase error. It will be necessary to make several sample calculations, since the normalized phase error is a function of ω_n .

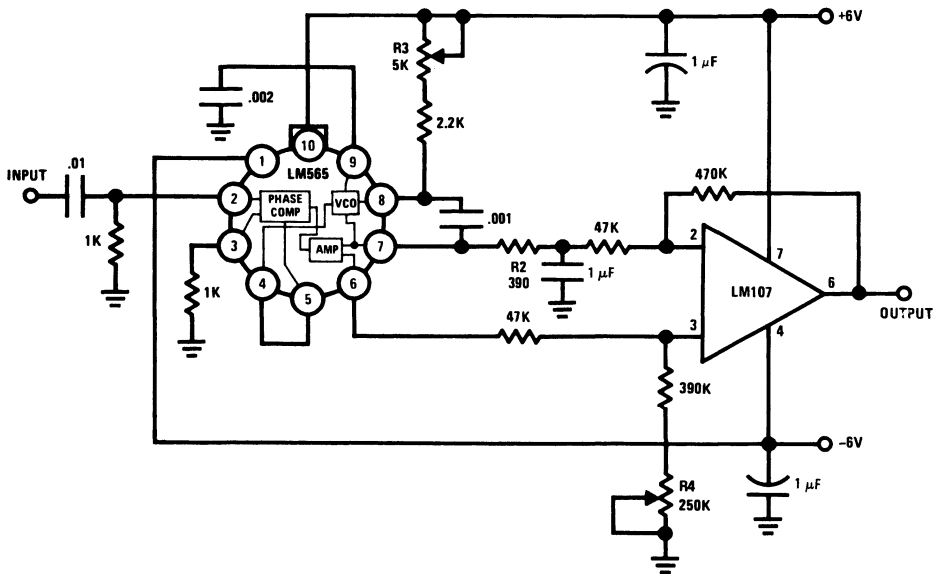


FIGURE 17. IRIG Channel 13 Demodulator

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Selecting a worst case of $\omega_n/\omega_m = 1$, $\omega_n = 2\pi \times 220$ Hz; selecting a damping factor of 0.707,

$$\frac{\theta}{\Delta\omega/\omega_n} = 0.702$$

or

$$\theta_e = 0.702 \frac{\Delta\omega}{\omega_n} = 0.702 \frac{2\pi \times 1088 \text{ Hz}}{2\pi \times 220 \text{ Hz}} = 3.45 \text{ radians}$$

this is unacceptable, since it would throw the loop out of lock, so it is necessary to try a higher value of ω_n . Let $\omega_n = 2\pi \times 500$ Hz, then $\omega_m/\omega_n = 0.44$, and

$$\theta_e = 0.44 \frac{\Delta\omega}{\omega_n} = 0.44 \times \frac{2\pi \times 1088}{2\pi \times 500} = 0.95 \text{ radians}$$

this should be a good choice, since it is close to 1 radian. Operating at 14.5 kHz, the LM565 has a loop gain K_oK_D of

$$2.28 \times 14.5 \times 10^3 = 33 \times 10^3 \text{ sec}$$

the value of the loop filter capacitor, C_1 , can be found from *Figure 4*:

$$\tau_1 + \tau_2 = 3.5 \times 10^{-3} \text{ sec}$$

from *Figure 5*, the value of τ_2 can be found (for a damping factor of 0.707)

$$\tau_2 = 4.4 \times 10^{-4} \text{ sec}$$

$$\tau_1 = (35 - 4.4) \times 10^{-4} \text{ sec} = 31.4 \times 10^{-4} \text{ sec}$$

$$C_1 = \frac{\tau_1}{R} = \frac{31.4 \times 10^{-4} \text{ sec}}{3.6 \text{ k}\Omega} \cong 1 \mu\text{F}$$

$$R_2 = \frac{4.4 \times 10^{-4} \text{ sec}}{1 \times 10^{-6} \mu\text{F}} = 440\Omega$$

Looking at *Figure 10*, the noise bandwidth B_L can be estimated to be

$$\begin{aligned} B_L &= 0.6 \omega_n = 0.6 \times 3150 \text{ rad/sec} \\ &= 1890 \text{ Hz} \end{aligned}$$

the complete circuit is shown in *Figure 17*. Measured performance of the circuit is summarized below with a fully modulated signal as described above and an input level of 40 mVrms:

f 3 dB	200
ζ	0.8
Output Level	770 mVrms
Distortion	0.4%
Signal to Noise at verge of loss of lock (bandwidth of noise = 100 kHz)	-8.4 dB

It will be noted that the loop is capable of demodulating signals lower in level than the noise; this is not in disagreement with earlier statements that loss of lock occurs at signal to noise ratios of approximately +6 dB because of the bandwidths involved. The above number of -8.4 dB signal to noise for threshold was obtained with a noise spectrum

100 kHz wide. The noise power in the loop will be reduced by the ratio of loop noise bandwidth to input noise bandwidth

$$\frac{B_{\text{LOOP}}}{B_{\text{INPUT}}} = \frac{1890 \text{ Hz}}{100 \text{ kHz}} = 0.02 \text{ or } -17 \text{ dB}$$

the equivalent signal to noise in the loop is -8.4 dB + 17 dB = +8.6 dB which is close to the above-mentioned limit of +6 dB. It should also be noted that loss of lock was noted with full modulation of the signal which will degrade threshold somewhat (although the measurement is more realistic).

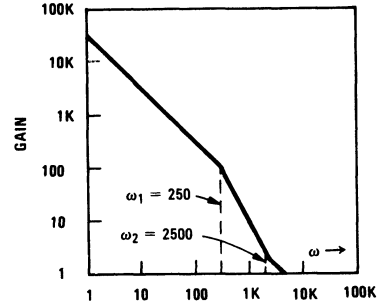


FIGURE 18. Bode Plot for Circuit of *Figure 17*

FSK DEMODULATOR

Frequency shift keying (FSK) is widely used for the transmission of Teletype information, both in the computer peripheral and communications field. Standards have evolved over the years, and the commonly used frequencies are as follows:

- | | | | |
|----|-------|------|----|
| a) | mark | 2125 | Hz |
| | space | 2975 | Hz |
| b) | mark | 1070 | Hz |
| | space | 1270 | Hz |
| c) | mark | 2025 | Hz |
| | space | 2225 | Hz |

(a) is commonly used as subcarrier tones for radio Teletype, while b) and c) are used as carriers for data transmission over telephone and land lines.

As a design example, a demodulator for the 2025 Hz and 2225 Hz mark and space frequencies will be discussed.

Since this is an FM system employing square wave modulation, the natural frequency of the loop must be chosen again so that peak phase errors do not exceed 90° under all conditions. *Figure 7* shows peak phase error for a step in frequency; if a damping factor of 0.707 is selected, the peak phase error is

$$\frac{\theta_e}{\Delta\omega/\omega_n} = 0.45$$

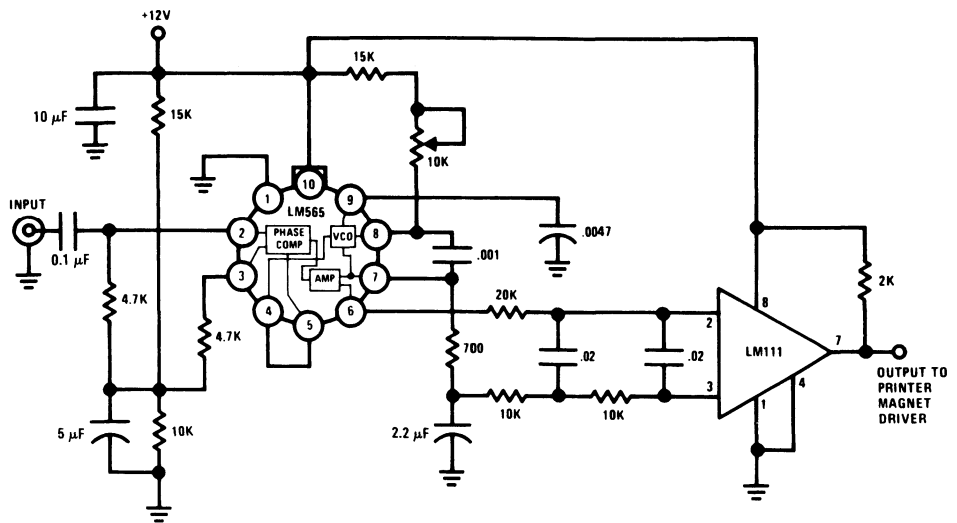


FIGURE 19. FSK Demodulator (2025-2225 cps)

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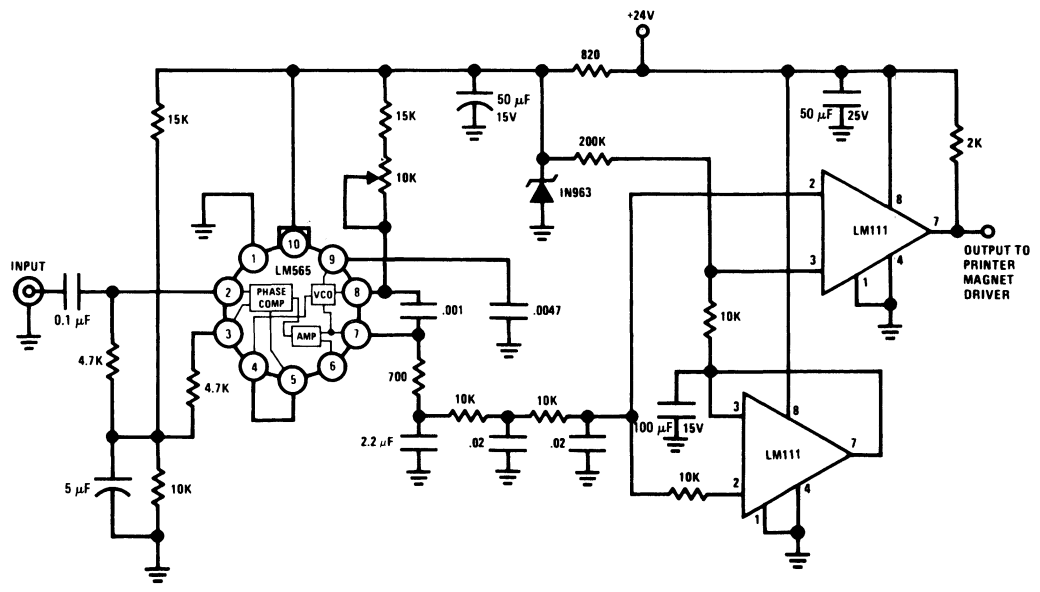
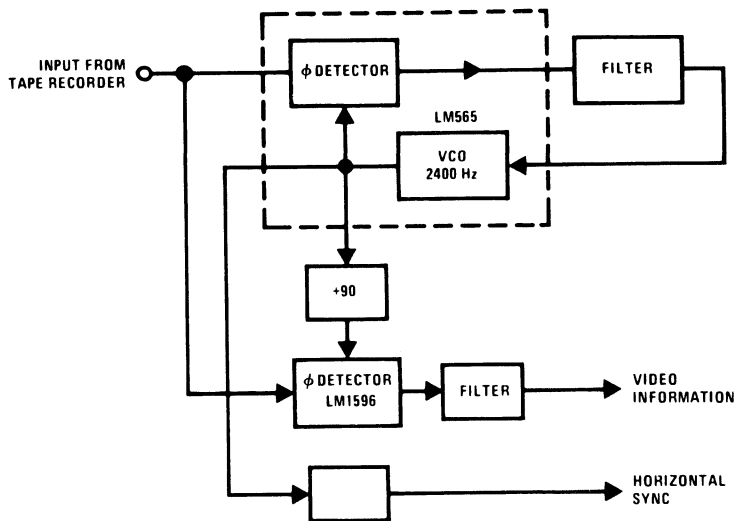


FIGURE 20. FSK Demodulator with DC Restoration

TL/H/7363-22



TL/H/7363-23

FIGURE 21. Block Diagram of Weather Satellite Demodulator

or

$$\theta_e = 0.45 \frac{\Delta\omega}{\omega_n}$$

$$\omega_n = 0.45 \frac{\Delta\omega}{\theta_e}$$

in our case, $\Delta\omega = 2\pi \times 200 \text{ Hz} = 1250$, if $\theta_e = 1$ radian,

$$\omega_n = 0.45 \frac{1250 \text{ rad/sec}}{1 \text{ radian}} = 500 \text{ rad/sec}$$

$$f_n = 80 \text{ Hz}$$

The final circuit is shown in *Figure 19*. The values of the loop filter components ($C_1 = 2.2 \mu\text{F}$ and $R_1 = 700\Omega$) were changed to accommodate a keying rate of 300 baud (150 Hz), since the values calculated above caused too much roll off of a square wave modulation signal of 150 Hz. The two 10k resistors and 0.02 μF capacitors at the input to the LM111 comparator provide further filtering of the carrier, and hence smoother operation of the circuit.

A problem encountered with this simple demodulator is that of dc drift. The frequency must be adjusted to provide zero volts to the input of the comparator so that with modulation, switching occurs. Since the deviation of the signal is small (approximately 10%), the peak to peak demodulated output is only 150 mV. It should be apparent that any drift in frequency of the VCO will cause a dc change and hence may lock the comparator in one state or the other. A circuit to overcome this problem is shown in *Figure 20*. While using the same basic demodulator configuration, an LM111 is used as an accurate peak detector to provide a dc bias for one input to the comparator. When a "space" frequency is transmitted, and the output at pin 7 of the LM565 goes neg-

ative and switching occurs, the detected and filtered voltage of pin 3 to the comparator will not follow the change. This is a form of "dc restorer" circuit: it will track changes in drift, making the comparator self compensating for changes in frequency, etc.

WEATHER SATELLITE PICTURE DEMODULATOR

As a last example of how a phase locked loop can be used in communications systems, a weather satellite picture demodulator is shown. Weather satellites of the Nimbus, ESSA, and ITOS series continually photograph the earth from orbits of 100 to 800 miles. The pictures are stored immediately after exposure in an electrostatic storage vidicon, and read out during a succeeding 200 second period. The video information is AM modulated on a 2.4 kHz subcarrier which is frequency modulated on a 137.5 MHz RF carrier. Upon reception, the output from the receiver FM detector will be the 2.4 kHz tone containing AM video information. It is common practice to record the tone on an audio quality tape recorder for subsequent demodulation and display. The 2.4 kHz subcarrier frequency may be divided by 600 to obtain the horizontal sync frequency of 4 Hz.

Due to flutter in the tape recorder, noise during reception, etc., it is desirable to reproduce the 2.4 kHz subcarrier with a phase locked loop, which will track any flutter and instability in the recorder, and effectively filter out noise, in addition to providing a signal large enough for the digital frequency divider. In addition, an in phase component of the VCO signal may be used to drive a synchronous demodulator to detect the video information. A block diagram of the system is shown in *Figure 21*, and a complete schematic in *Figure 22*.

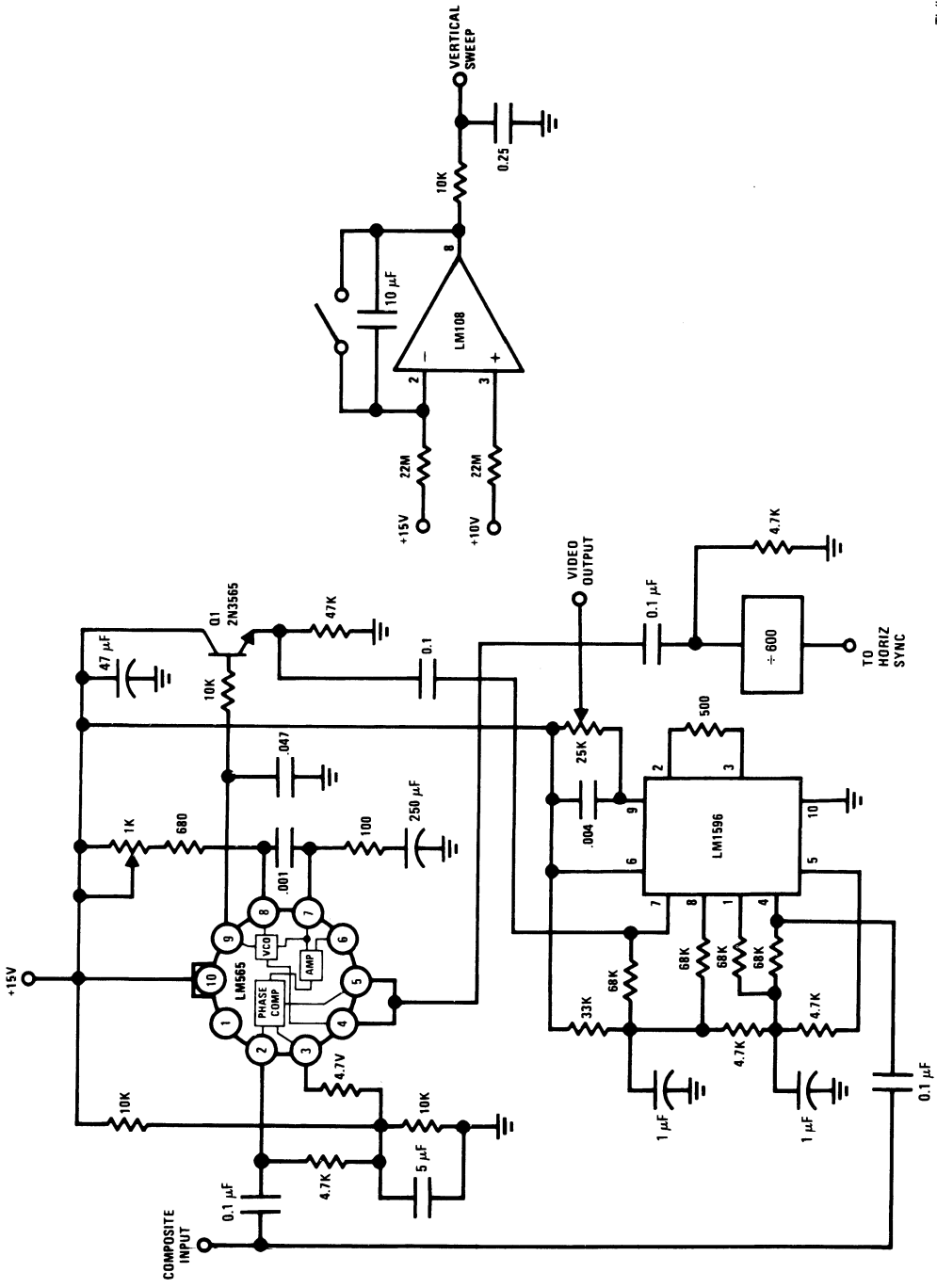


FIGURE 22. Weather Satellite Picture Demodulator

The design of the loop parameters was based on the following objectives

$$f_n = 10 \text{ Hz}, \omega_n = 75 \text{ rad/sec}$$

$$B_L = 40 \text{ Hz (from Figure 10)}$$

the complete loop filter, calculated from *Figures 4 and 5*, is shown in *Figure 22*. When the loop is in lock and the free running frequency of the VCO is 2.4 kHz, the VCO square wave at pin 4 of the 565 will be in quadrature (90°) with the input signal; however, the zero crossings of the triangle wave across the timing capacitor will be in phase, and if their signal is applied to a double balanced demodulator, such as an LM1596, switching will occur in the demodulator in phase with the 2.4 kHz subcarrier. The double balanced demodulator will produce an output proportional to the amplitude of the subcarrier applied to its signal input. An emitter follower, Q_1 , is used to buffer the triangle wave across the timing capacitor so excessive loading does not occur.

The demodulated video signal from the LM1596 is taken across a 25k potentiometer and filtered to a bandwidth of 1.4 kHz, the bandwidth of the transmitted video. Depending on the type of display to be used (oscilloscope, slow scan TV monitor, facsimile reproducer), it may be necessary to further buffer or amplify the signal obtained. If desired, another load resistor may be used between pin 6 and VCO to obtain a differential output; an operational amp could then be used to provide more gain, level shift, etc.

A vertical sweep circuit is shown using an LM308 low input current op amp as a Miller rundown circuit. The values are chosen to produce an output voltage ramp of $-4.5V/220$ sec, although this may be adjusted by means of the 22 meg. charging resistor. If an oscilloscope is used as a readout, the horizontal sync can be supplied to the trigger input with the sweep set to provide a total sweep time of something less than 250 ms. A camera is used to photograph the 200 second picture.

SUMMARY AND CONCLUSIONS

A brief review of phase lock techniques has been presented and several design tools have been presented that may be useful in predicting the performance of phase locked loops.

A phase locked loop integrated circuit has been described and several applications have been given to illustrate the use of the circuit and the design techniques presented.

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2. Elliot L. Greenberg, "Handbook of Telemetry and Remote Control", *McGraw-Hill*, 1967.
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Applications for a New Ultra-High Speed Buffer

National Semiconductor
Application Note 48



INTRODUCTION

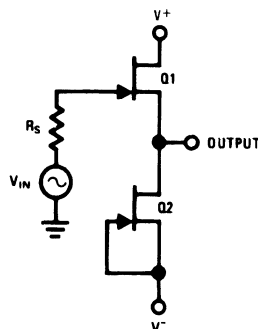
Voltage followers have gained in popularity in applications such as sample and hold circuits, general purpose buffers, and active filters since the introduction of IC operational amplifiers. Since they were not specifically designed as followers, these early IC's had limited usage due to low bandwidth, low slew rate and high input current. Usage of voltage followers was expanded in 1967 with the introduction of the LM102, the first IC designed specifically as a voltage follower. With the LM102, engineers were able to obtain an order of magnitude improvement in performance and extend usage into medium speed applications. The LM110, an improved LM102, was introduced in late 1969. However, even higher speeds and lower input currents were needed for very fast sample and holds, A to D and D to A converters, coax cable drivers, and other video applications.

The solution to this application problem was attained by combining technologies into a single package. The result, the LH0033 high speed buffer, utilizes JFET and bipolar technology to produce an ultra-fast voltage follower and buffer whose propagation delay closely approaches speed-of-light delay across its package, while not compromising input impedance or drive characteristics. Table I compares various voltage followers and illustrates the superiority of the LH0033 in both low input current or high speed video applications.

CIRCUIT CONSIDERATIONS

The junction FET makes a nearly ideal input device for a voltage follower, reducing input bias current to the picoamp range. However, FET's exhibit moderate voltage offsets and offset drifts which tend to be difficult to compensate. The simple voltage follower of *Figure 1* eliminates initial offset and offset drift if Q_1 and Q_2 are identically matched transistors. Since the gate to source voltage of Q_2 equals zero volts, then Q_1 's gate to source voltage equals zero volts. Furthermore as V_{P1} changes with temperature (approximately 2.2 mV/°C), V_{P2} will change by a corresponding amount. However, as load current is drawn from the output, Q_1 and Q_2 will drift at different rates. A circuit which overcomes offset voltage drift is used in a new high speed buffer amplifier, the LH0033. Initial offset is typically 5 mV and offset drift is 20 μ V/°C. Resistor R_2 is used to establish the drain current of current source transistor, Q_2 at 10 mA.

The same drain current flows through Q_1 causing a voltage at the source of approximately 1.1V. The 10 mA flowing through R_1 plus Q_3 's V_{BE} of 0.6V causes the output to sit at



TL/K/7318-1

FIGURE 1. Simple Voltage Follower Schematic

zero volts for zero volts in. Q_3 and Q_4 eliminate loading the input stage (except for base current) and CR_1 and CR_2 establish the output stage collector current.

If Q_1 and Q_2 are matched, the resulting drift is reduced to a few μ V/°C.

PERFORMANCE OF THE LH0033 FAST VOLTAGE FOLLOWER/BUFFER

The major electrical characteristics of the LH0033 are summarized in Table II. All the virtues of a ultra-high speed buffer have been incorporated.

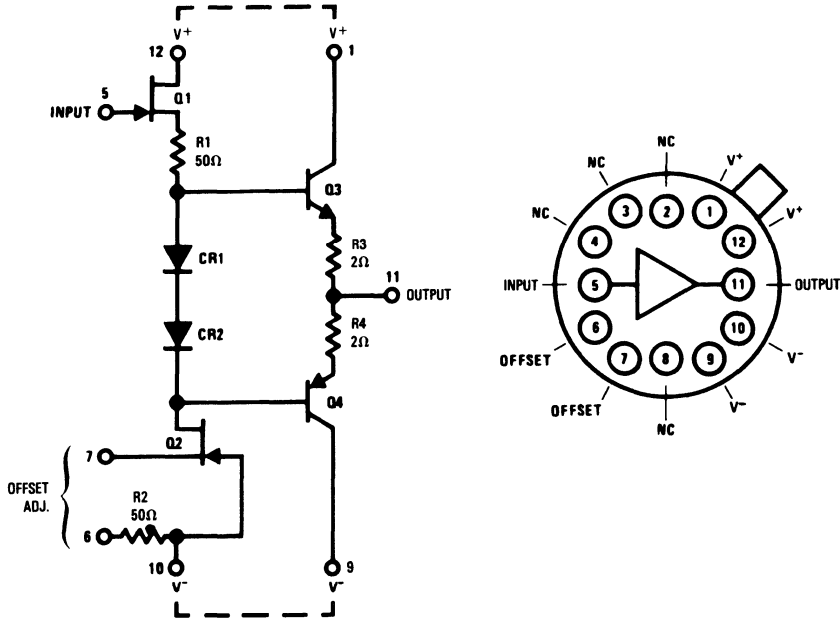
Figure 3 is a plot of input bias current vs temperature and shows the typical FET input characteristics. Other typical performance curves are illustrated in *Figures 4* through *10*. Of particular interest is *Figure 8*, which demonstrates the performance of the LH0033 in video applications to over 100 MHz.

APPLICATIONS FOR ULTRA-FAST FOLLOWERS

The LH0033's high input impedance ($10^{11} \Omega$, shunted by 2 pF) and high slew rate assure minimal loading and high fidelity in following high speed pulses and signals. As shown below, the LH0033 is used as a buffer between MOS logic and a high speed dual limit comparator. The device's high input impedance prevents loading of the MOS logic signal (even a conventional scope probe will distort high output impedance MOS). The LH0033 adds about a 1.5 ns to the total delay of the comparator. Adjustment of voltage divider R_1 , R_2 allows interface to TTL, DTL and other high speed logic forms.

TABLE I. COMPARISON OF VOLTAGE FOLLOWERS

Parameter	Conventional Monolithic Op Amp LM741	First Generation Voltage Follower LM102	Second Generation Voltage Follower LM110	Specially Designed Voltage Follower LH0033
Input Bias Current	200 nA	3.0 nA	1.0 nA	0.05 nA
Slew Rate	0.5 V/ μ s	10V/ μ s	30V/ μ s	1500V/ μ s
Bandwidth	1.0 MHz	10 MHz	20 MHz	100 MHz
Prop. Delay Time	350 ns	35 ns	18 ns	1.2 ns
Output Current Capability	± 5 mA	± 2 mA	± 2 mA	± 100 mA



Top View

FIGURE 2. LH0033 Schematic

TL/K/7318-2

TABLE II

Parameter	Conditions	Value	Parameter	Conditions	Value
Output Offset Voltage	$R_S = 100\text{ k}\Omega$	5 mV	Output Current Capability		$\pm 100\text{ mA peak}$
Input Bias Current		50 pA	Slew Rate	$R_S = 50\Omega, R_L = 1\text{ k}$	$1500\text{ V}/\mu\text{s}$
Input Impedance	$V_{IN} = 1.0\text{ Vrms}$ $R_L = 1\text{ k}, f = 1\text{ kHz}$	$10^{11}\ \Omega$	Propagation Delay		1.2 ns
Voltage Gain	$V_{IN} = 1.0\text{ Vrms}$ $R_L = 1\text{ k}, f = 1\text{ kHz}, R_S = 100\text{ k}$	0.98	Bandwidth	$V_{IN} = 1.0\text{ Vrms}$ $R_S = 50\Omega, R_L = 1\text{ k}$	100 MHz
Output Voltage Swing	$V_S = \pm 15\text{ V}, R_S = 100\text{ k}$ $R_L = 1\text{ k}$	$\pm 13\text{ V}$			

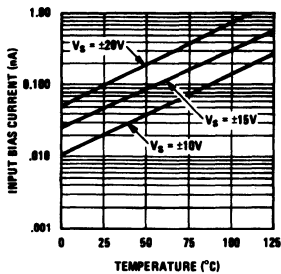


FIGURE 3. Input Bias Current vs Temperature

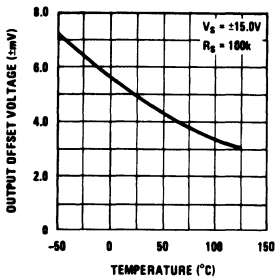


FIGURE 4. Output Offset Voltage vs Temperature

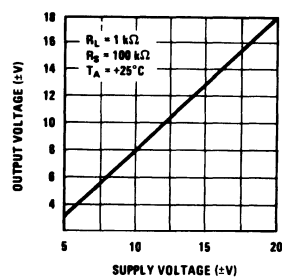


FIGURE 5. Output Voltage vs Supply Voltage

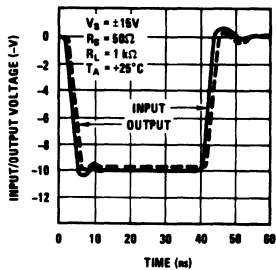


FIGURE 6. Negative Pulse Response

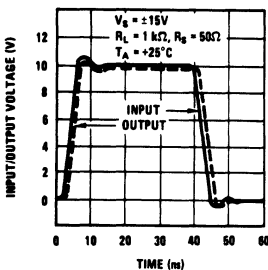


FIGURE 7. Positive Pulse Response

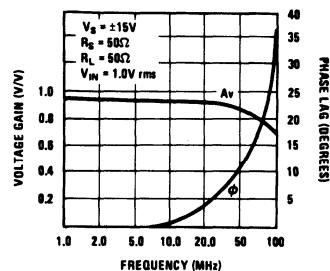


FIGURE 8. Frequency Response

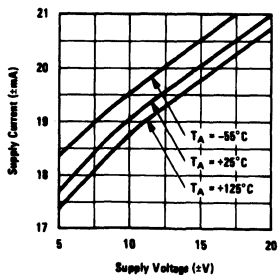


FIGURE 9. Supply Current vs Supply Voltage

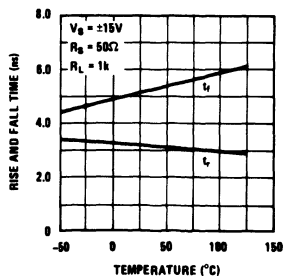
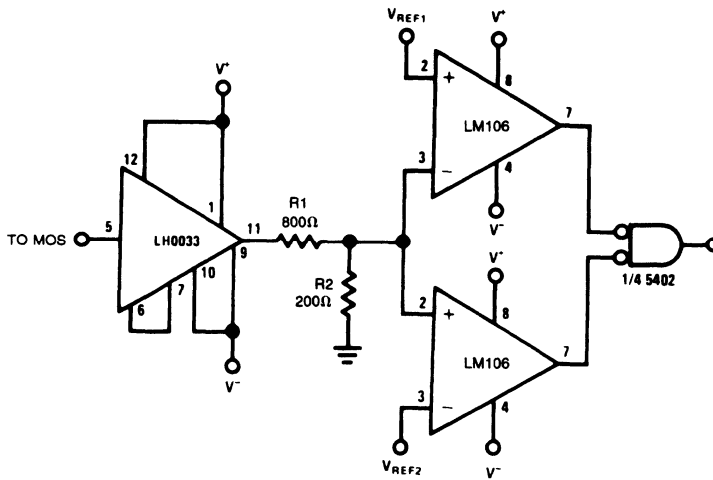


FIGURE 10. Rise and Fall Time vs Temperature

TL/K/7318-3

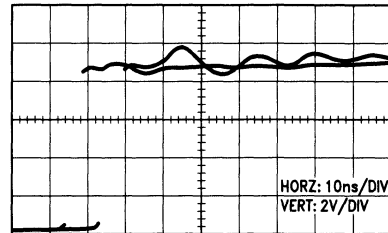


TL/K/7318-4

FIGURE 11. High Speed Dual Limit Comparator for MOS Logic

The LH0033 was designed to drive long cables, shielded cables, coaxial cables and other generally stringent line driving requirements. It will typically drive 200 pF with no degradation in slew rate and several thousand pF at a reduced rate. In order to prevent oscillations with large capacitive loads, provision has been made to insert damping resistors between V^+ and pin 1, and V^- and pin 9. Values between 47 and 100Ω work well for $C_L > 1000$ pF. For non-reactive loads, pin 12 should be shorted to pin 1 and pin 10 shorted to pin 9. A coaxial driver is shown in Figure 13. Pin 6 is shorted to pin 7, obtaining an initial offset of 5.0 mV, and the 43Ω coupled with the LH0033's output impedance (about 6Ω) match the coaxial cable's characteristic impedance. C_1 is adjusted as a function of cable length to optimize rise and fall time. Rise time for the circuit as shown in Figure 12, is 10 ns.

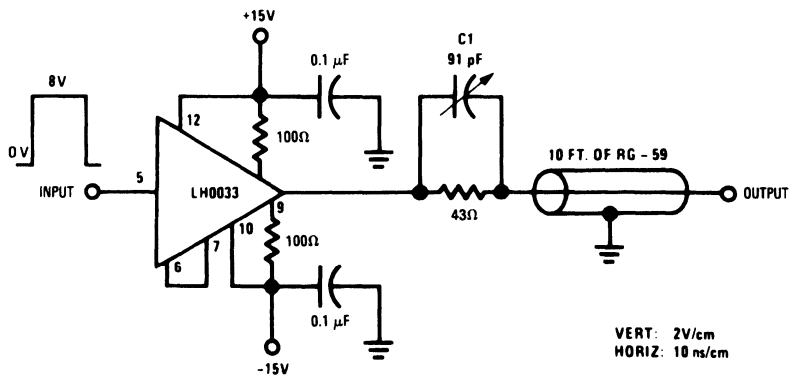
close to the device under test and drives the cable shield thus allowing higher speed operation since the device under test does not have to charge the cable.



TL/K/7318-5

FIGURE 12. LH0033 Pulse Response Into 10 Foot Open Ended Coaxial Cable

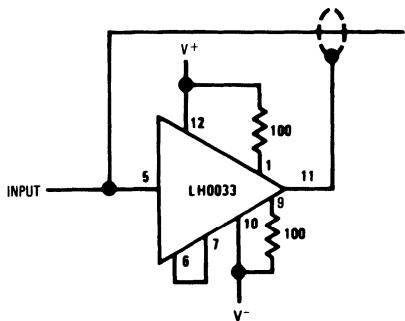
Another application that utilizes the low input current, high speed and high capacitance drive capabilities of the LH0033 is a shield or line driver for high speed automatic test equipment. In this example, the LH0033 is mounted



VERT: 2V/cm
HORIZ: 10 ns/cm

FIGURE 13

TL/K/7318-6



TL/K/7318-7

FIGURE 14. Instrumentation Shield/Line Driver

The LH0033's high input impedance and low input bias current may be utilized in medium speed circuits such as Sample and Hold, and D to A converters. *Figure 15* shows an LH0033 used as a buffer in medium speed D to A converter.

Offset null is accomplished by connecting a 100Ω pot between pin 7 and V⁻. It is generally a good idea to insert 20Ω in series with the pot to prevent excessive power dissipation in the LH0033 when the pot is shorted out. In non-critical or AC coupled applications, pin 6 should be shorted to pin 7. The resulting output offset is typically 5 mV at 25°C.

The high output current capability and slew rate of the LH0033 are utilized in the sample and hold circuit of *Figure 16*. Amplifier, A1 is used to buffer high speed analog signals. With the configuration shown, acquisition time is limited by the time constant of the switch "ON" resistance and sampling capacitor, and is typically 200 or 300 ns.

A₂'s low input bias current, results in drifts in hold mode of

$$\frac{50 \text{ mV}}{\text{sec}} \text{ at } 25^{\circ}\text{C} \quad \text{and} \quad \frac{1 \text{ V}}{\text{sec}} \text{ at } 125^{\circ}\text{C}.$$

The LH0033 may be utilized in AC applications such as video amplifiers and active filters. The circuit of *Figure 17* utilizes boot strapping to achieve input impedances in excess of 10 MΩ.

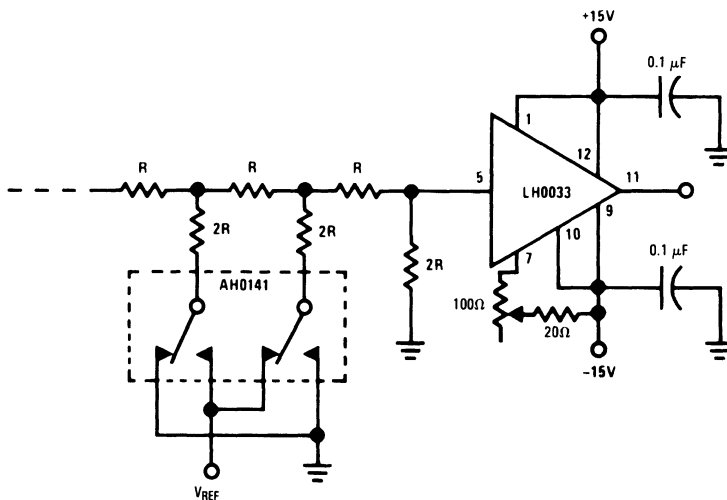


FIGURE 15

TL/K/7318-8

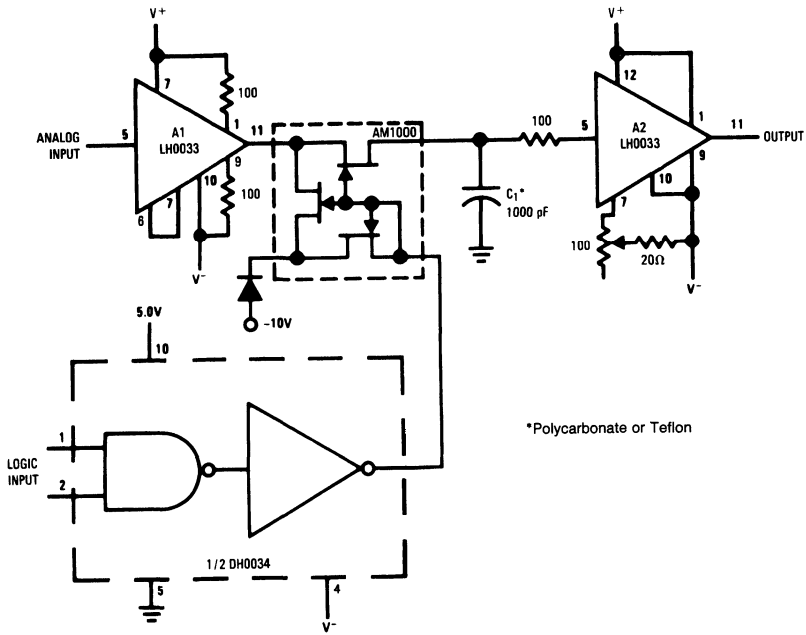
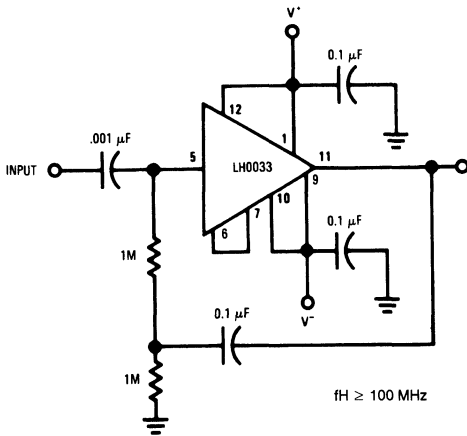


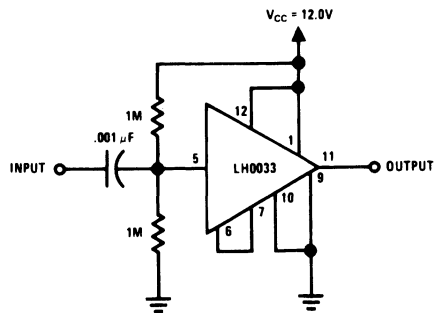
FIGURE 16. High Speed Sample and Hold

TL/K/7318-9



TL/K/7318-10

FIGURE 17. High Input Impedance AC Coupled Amplifier



TL/K/7318-11

FIGURE 18. Single Supply AC Amplifier

A single supply, AC coupled amplifier is shown in *Figure 18*. Input impedance is approximately 500k and output swing is in excess of 8V peak-to-peak with a 12V supply.

The LHM033 may be readily used in applications where symmetrical supplies are unavailable or may not be desirable. A

typical application might be an interface to a MOS shift register where $V^+ = 5.0V$ and $V^- = -25V$. In this case, an apparent output offset occurs. In reality, the output voltage is due to the LHM033's voltage gain of less than unity.

The output voltage shift due to asymmetrical supplies may be predicted by:

$$\Delta V_O \cong (1 - A_v) \frac{(V^+ - V^-)}{2} = .005 (V^+ - V^-)$$

where: A_v = No load voltage gain, typically 0.99.

V^+ = Positive Supply Voltage.

V^- = Negative Supply Voltage.

For the foregoing application, ΔV_O would be -100 mV. This apparent "offset" may be adjusted to zero as outlined above.

Figure 19 shows a high Q, notch filter which takes advantage of the LH0033's wide bandwidth. For the values shown, the center frequency is 4.5 MHz.

The LH0033 can also be used in conjunction with an operational amplifier as current booster as shown in Figure 20.

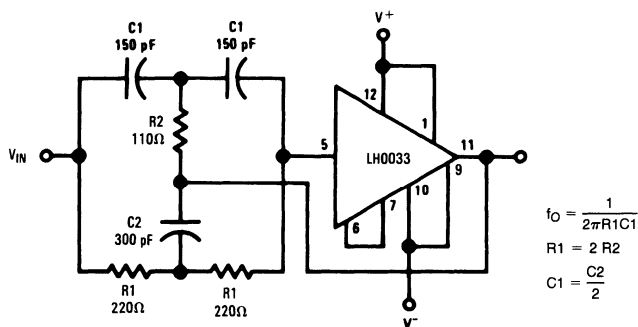
Output currents in excess of 100 mA may be obtained. Inclusion of 150Ω resistors between pins 1 and 12, and 9 and 10 provide short circuit protection, while decoupling pins 1 and 9 with 1000 pF capacitors allow near full output swing. The value for the short circuit current is given by:

$$I_{SC} \cong \frac{V^+}{R_{LIMIT}} = \frac{V^-}{R_{LIMIT}}$$

where: $I_{SC} \leq 100$ mA.

SUMMARY

The advantages of a FET input buffer have been demonstrated. The LH0033 combined very high input impedance, wide bandwidth, very high slew rate, high output capability, and design flexibility, making it an ideal buffer for applications ranging from DC to in excess of 100 MHz.



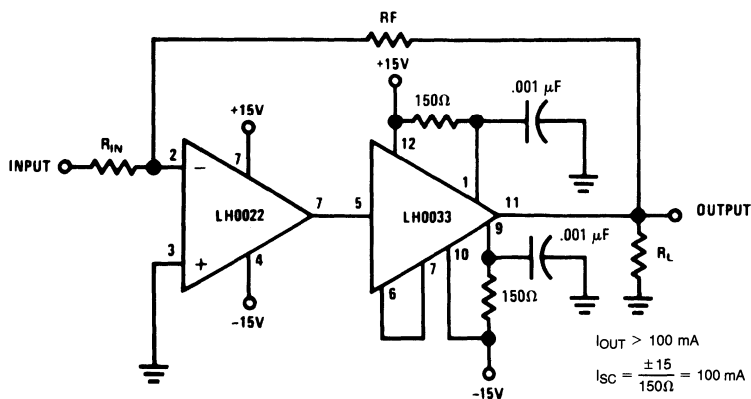
$$f_o = \frac{1}{2\pi R_1 C_1}$$

$$R_1 = 2 R_2$$

$$C_1 = \frac{C_2}{2}$$

TL/K/7318-12

FIGURE 19. 4.5 MHz Notch Filter



$$I_{OUT} > 100 \text{ mA}$$

$$I_{SC} = \frac{\pm 15}{150\Omega} = 100 \text{ mA}$$

TL/K/7318-13

FIGURE 20. Using LH0033 as an Output Buffer

PIN Diode Drivers

National Semiconductor
Application Note 49



INTRODUCTION

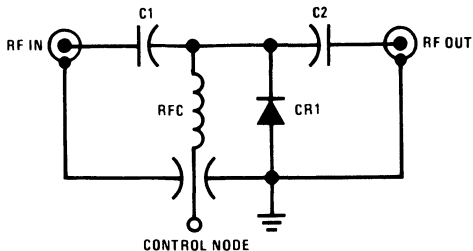
The DH0035/DH0035C is a TTL/DTL compatible, DC coupled, high speed PIN diode driver. It is capable of delivering peak currents in excess of one ampere at speeds up to 10 MHz. This article demonstrates how the DH0035 may be applied to driving PIN diodes and comparable loads which require high peak currents at high repetition rates. The salient characteristics of the device are summarized in Table I.

TABLE I. DH0035 Characteristics

Parameter	Conditions	Value
Differential Supply Voltage ($V^+ - V^-$)		30V Max.
Output Current		1000 mA
Maximum Power		1.5W
t_{delay}	PRF = 5.0 MHz	10 ns
t_{rise}	$V^+ - V^- = 20V$ 10% to 90%	15 ns
t_{fall}	$V^+ - V^- = 20V$ 90% to 10%	10 ns

PIN DIODE SWITCHING REQUIREMENTS

Figure 1 shows a simplified schematic of a PIN diode switch. Typically, the PIN diode is used in RF through microwave frequency modulators and switches. Since the diode is in shunt with the RF path, the RF signal is attenuated when the diode is forward biased ("ON"), and is passed unattenuated when the diode is reversed biased ("OFF"). There are essentially two considerations of interest in the "ON" condition. First, the amount of "ON" control current must be sufficient such that RF signal current will not significantly modulate the "ON" impedance of the diode. Secondly, the time required to achieve the "ON" condition must be minimized.



TL/H/8750-1

FIGURE 1. Simplified PIN Diode Switch

The charge control model of a diode^{1,2} leads to the charge continuity equation given in equation (1).

$$i = \frac{dQ}{dt} + \frac{Q}{\tau} \quad (1)$$

where: Q = charge due excess minority carriers

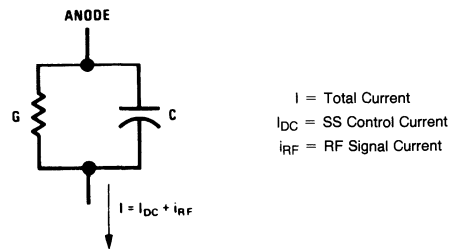
τ = mean lifetime of the minority carriers

Equation (1) implies a circuit model shown in Figure 2. Under

steady conditions $\frac{dQ}{dt} = 0$, hence:

$$I_{DC} = \frac{Q}{\tau} \text{ or } Q = I_{DC} \cdot \tau \quad (2)$$

where: I = steady state "ON" current.



TL/H/8750-2

FIGURE 2. Circuit Model for PIN Switch

The conductance is proportional to the current, I ; hence, in order to minimize modulation due to the RF signal, $I_{DC} \gg I_{RF}$. Typical values for I_{DC} range from 50 mA to 200 mA depending on PIN diode type, and the amount of modulation that can be tolerated.

The time response of the excess charge, Q , may be evaluated by taking the Laplace transform of equation (1) and solving for Q :

$$Q(s) = \frac{\tau I(s)}{1 + s\tau} \quad (3)$$

Solving equation (3) for $Q(t)$ yields:

$$Q(t) = L^{-1} [Q(s)] = I\tau (1 - e^{-t/\tau}) \quad (4)$$

The time response of Q is shown in Figure 3a. As can be seen, several carrier lifetimes are required to achieve the steady state "ON" condition ($Q = I_{DC} \cdot \tau$).

The time response of the charge, hence the time for the diode to achieve the "ON" state could be shortened by applying a current spike, I_{pk} , to the diode and then dropping the current to the steady state value, I_{DC} , as shown in Figure 3b. The optimum response would be dictated by:

$$(I_{pk})(t) = \tau \cdot I_{DC} \quad (5)$$

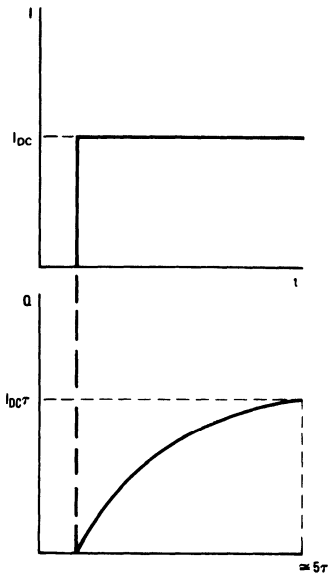


FIGURE 3a

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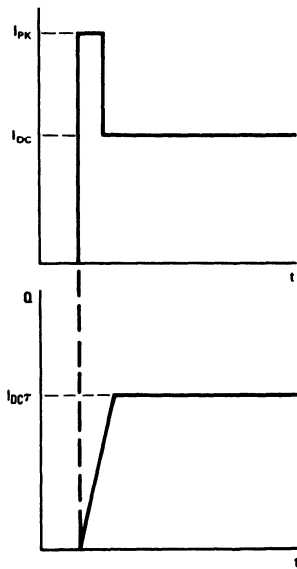


FIGURE 3b

TL/H/8750-4

The turn off requirements for the PIN diode are quite similar to the turn on, except that in the "OFF" condition, the steady current drops to the diode's reverse leakage current. A charge, $I_{DC} \cdot \tau$, was stored in the diode in the "ON" condition and in order to achieve the "OFF" state this charge must be removed. Again, in order to remove the charge rapidly, a large peak current (in the opposite direction) must be applied to the PIN diode:

$$-I_{pk} \geq \frac{Q}{\tau} \quad (6)$$

It is interesting to note an implication of equation (5). If the peak turn on current were maintained for a period of time, say equal to τ , then the diode would acquire an excess charge equal to $I_{pk} \cdot T$. This same charge must be removed at turn off, instead of a charge $I_{DC} \cdot \tau$, resulting in a considerably slower turn off. Accordingly, control of the width of turn on current peak is critical in achieving rapid turn off.

APPLICATION OF THE DH0035 AS A PIN DIODE DRIVER

The DH0035 is specifically designed to provide both the current levels and timing intervals required to optimally drive PIN diode switches. Its schematic is shown in Figure 4. The device utilizes a complementary TTL input buffer such as the DM7830/DM8830 or DM5440/DM7440 for its input signals.

Two configurations of PIN diode switch are possible: cathode grounded and anode grounded. The design procedures for the two configurations will be considered separately.

ANODE GROUND DESIGN

Selection of power supply voltages is the first consideration. Table I reveals that the DH0035 can withstand a total of 30V differentially. The supply voltage may be divided symmetrically at $\pm 15V$, for example. Or asymmetrically at $+20V$ and $-10V$. The PIN diode driver shown in Figure 5, uses $\pm 10V$ supplies.

When the Q output of the DM8830 goes high a transient current of approximately 50 mA is applied to the emitter of Q_1 and in turn to the base of Q_5 .

Q_5 has an $h_{fe} = 20$, and the collector current is $h_{fe} \times 50$ or 1000 mA. This peak current, for the most part, is delivered to the PIN diode turning it "ON" (RF is "OFF").

I_{pk} flows until C_2 is nearly charged. This time is given by:

$$t = \frac{C_2 \Delta V}{I_{pk}} \quad (7)$$

where: ΔV = the change in voltage across C_2 .

Prior to Q_5 's turn on, C_2 was charged to the minus supply voltage of $-10V$. C_2 's voltage will rise to within two diode drops plus a V_{sat} of ground:

$$V = |V^-| - V_f(\text{PIN Diode}) - V_{fCR1} - V_{satQ5} \quad (8)$$

for $V^- = -10V$, $\Delta V = 8V$.

Once C_2 is charged, the current will drop to the steady state value, I_{DC} , which is given by:

$$I_{DC} = \frac{V}{R_M} - \frac{V^+}{R_3} - \frac{V_{CC}}{R_1} \quad (9)$$

where: $V_{CC} = 5.0V$
 $R_1 = 250\Omega$
 $R_3 = 500\Omega$

$$\therefore R_M = \frac{(R_3 (\Delta V) (R_1))}{R_1 V^+ + I_{DC} R_3 R_1 + V_{CC} R_3} \quad (9a)$$

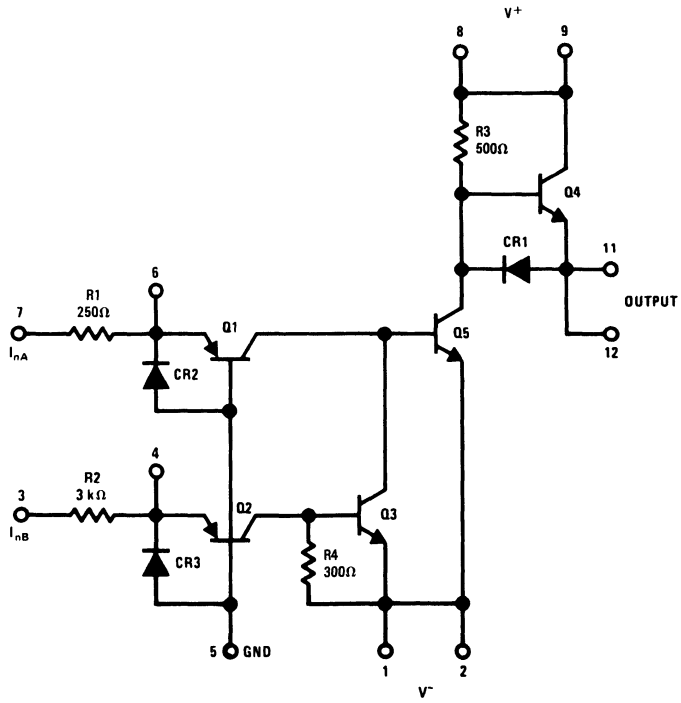


FIGURE 4. DH0035 Schematic Diagram

TL/H/8750-5

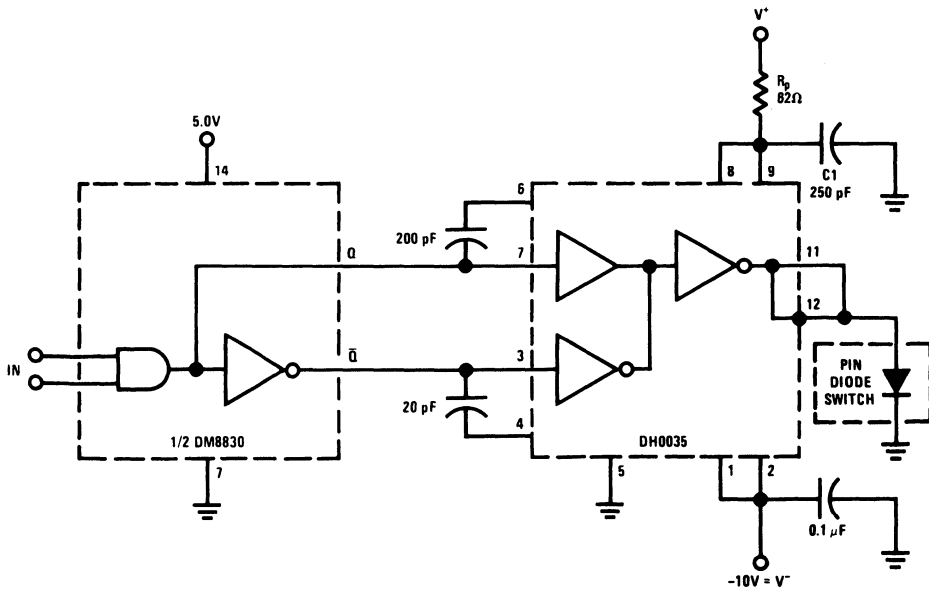


FIGURE 5. Cathode Grounded Design

TL/H/8750-6

For the driver of *Figure 5*, and $I_{DC} = 100$ mA, R_M is 56 Ω (nearest standard value).

Returning to equation (7) and combining it with equation (5) we obtain:

$$t = \frac{\tau I_{DC}}{I_{pk}} = \frac{C_2 V}{I_{pk}} \quad (10)$$

Solving equation (10) for C_2 gives:

$$C_2 = \frac{I_{DC} \tau}{V} \quad (11)$$

For $\tau = 10$ ns, $C_2 = 120$ pF.

One last consideration should be made with the diode in the "ON" state. The power dissipated by the DH0035 is limited to 1.5W (see Table I). The DH0035 dissipates the maximum power with Q_5 "ON". With Q_5 "OFF", negligible power is dissipated by the device. Power dissipation is given by:

$$P_{diss} \cong \left[I_{DC} (|V^-| - \Delta V) + \frac{(V^+ - V^-)^2}{R_3} \right] \times (\text{D.C.}) \leq P_{max} \quad (12)$$

where: D.C. = Duty Cycle =

$$\frac{(\text{"ON" time})}{(\text{"ON" time} + \text{"OFF" time})}$$

$$P_{max} = 1.5W$$

In terms of I_{DC} :

$$I_{DC} \leq \frac{\left[\frac{(P_{max})}{(\text{D.C.})} - \frac{(V^+ - V^-)^2}{500} \right]}{|V^-| - \Delta V} \quad (12a)$$

For the circuit of *Figure 5* and a 50% duty cycle, $P_{diss} = 0.5W$.

Turn-off of the PIN diode begins when the Q output of the DM8830 returns to logic "0" and the \bar{Q} output goes to logic "1". Q_2 turns "ON", and in turn, causes Q_3 to saturate. Simultaneously, Q_1 is turned "OFF" stopping the base drive

to Q_5 . Q_3 absorbs the stored base charge of Q_5 facilitating its rapid turn-off. As Q_5 's collector begins to rise, Q_4 turns "ON". At this instant, the PIN diode is still in conduction and the emitter of Q_4 is held at approximately $-0.7V$. The instantaneous current available to clear stored charge out of the PIN diode is:

$$I_{pk} = \frac{V^+ - V_{BE Q4} + V_{f(PIN)}}{R_3}$$

$$\cong \frac{(h_{fe} + 1)(V^+)}{R_3} \quad (13)$$

where:

$h_{fe} + 1 =$ current gain of $Q_4 = 20$

$V_{BE Q4} =$ base-emitter drop of $Q_4 = 0.7V$

$V_{f(PIN)} =$ forward drop of the PIN diode = 0.7V

For typical values given, $I_{pk} = 400$ mA. Increasing V^+ above 10V will improve turn-off time of the diode, but at the expense of power dissipation in the DH0035. Once turn-off of the diode has been achieved, the DH0035 output current drops to the reverse leakage of the PIN diode. The attendant power dissipation is reduced to about 35 mW.

CATHODE GROUND DESIGN

Figure 6 shows the DH0035 driving a cathode grounded PIN diode switch. The peak turn-on current is given by:

$$I_{pk} \cong \frac{(V^+ - V^-)(h_{fe} + 1)}{R_3} \quad (14)$$

= 800 mA for the values shown.

The steady state current, I_{DC} , is set by R_p and is given by:

$$I_{DC} = \frac{(V^+ - 2V_{BE})}{R_3 + R_p + h_{fe} + 1} \quad (15)$$

where: $2V_{BE} =$ forward drop of Q_4 base emitter junction plus V_f of the PIN diode = 1.4V.

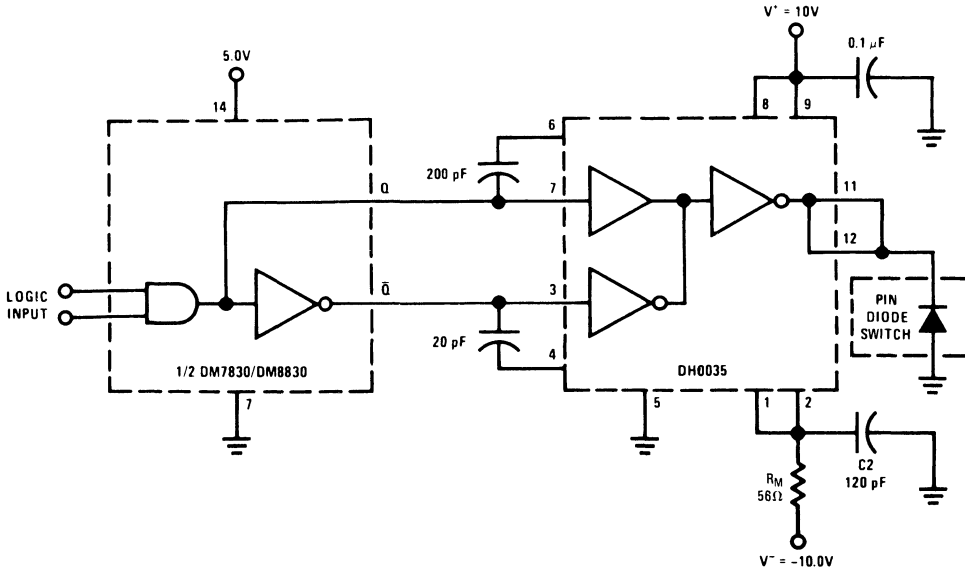


FIGURE 6. Anode Grounded Driver

TL/H/8750-7

In terms of R_p , equation (15) becomes:

$$R_p = \frac{(h_{fe} + 1)(V^+ - 2V_{BE}) - I_{DC}R_9}{(h_{fe} + 1)I_{DC}} \quad (15a)$$

For the circuit of Figure 6, and $I_{DC} = 100$ mA, R_p is 62 Ω (nearest standard value).

It now remains to select the value of C_1 . To do this, the change in voltage across C_1 must be evaluated. In the "ON" state, the voltage across C_1 , V_c , is given by:

$$(V_c)_{ON} = \frac{V^+R_3 + R_p(h_{fe} + 1)(2V_{BE})}{R_3 + (h_{fe} + 1)R_p} \quad (16)$$

For the values indicated above, $(V_c)_{ON} = 3.8$ V.

In the "OFF" state, V_c is given by:

$$(V_c)_{OFF} = \frac{V^+R_3 - |V^-|R_p}{R_p + R_3} \quad (17)$$

= 8.0 V for the circuit of Figure 6.

Hence, the change in voltage across C_1 is:

$$V = (V_c)_{OFF} - (V_c)_{ON} \quad (18)$$

= 8.0 - 3.8
= 4.2 V

The value of C_4 is given, as before, by equation (11):

$$C_1 = \frac{I_{DC}\tau}{V^-} \quad (19)$$

For a diode with $\tau = 10$ ns and $I_{DC} = 100$ mA, $C_1 = 250$ pF.

Again the power dissipated by the DH0035 must be considered. In the "OFF" state, the power dissipation is given by:

$$P_{OFF} = \left[\frac{V^+ - V^-}{R_3} \right]^2 (D.C.) \quad (20)$$

where: D.C. = duty cycle =

$$\frac{\text{"OFF" time}}{\text{"OFF" time} + \text{"ON" time}}$$

The "ON" power dissipation is given by:

$$P_{ON} = \left[\frac{(V_c)_{ON}^2}{R_3} + I_{DC} \times (V_c)_{ON} \right] (1 - D.C.) \quad (21)$$

where: $(V_c)_{ON}$ is defined by equation (16).

Total power dissipated by the DH0035 is simply $P_{ON} + P_{OFF}$. For a 50% duty cycle and the circuit of Figure 6, $P_{diss} = 616$ mW.

The peak turn-off current is, as indicated earlier, equal to 50 mA \times h_{fe} which is about 1000 mA. Once the excess stored charge is removed, the current through Q_5 drops to the diodes leakage current. Reverse bias across the diode = $V^- - V_{sat} \approx -10$ V for the circuit of Figure 6.

REPETITION RATE CONSIDERATIONS

Although ignored until now, the PRF, in particular, the "OFF" time of the PIN diode is important in selection of C_2 , R_M , and C_1 , R_p . The capacitors must recharge completely during the diode "OFF" time. In short:

$$4 R_M C_2 \leq t_{OFF} \quad (22a)$$

$$4 R_p C_1 \leq t_{OFF} \quad (22b)$$

CONCLUSION

The circuit of *Figure 6* was breadboarded and tested in conjunction with a Hewlett-Packard 33622A PIN diode.

I_{DC} was set at 100 mA, $V^+ = 10V$, $V^- = 10V$. Input signal to the DM8830 was a 5V peak, 100 kHz, 5 μ s wide pulse train. RF turn-on was accomplished in 10–12 ns while turn-off took approximately 5 ns, as shown in *Figures 7* and *8*.

In practice, adjustment C_2 (C_1) may be required to accommodate the particular PIN diode minority carrier lifetime.

SUMMARY

A unique circuit utilized in the driving of PIN diodes has been presented. Further a technique has been demonstrated which enables the designer to tailor the DH0035 driver to the PIN diode application.

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1.2V Reference

National Semiconductor
Application Note 56



INTRODUCTION

Temperature compensated zener diodes are the most easily used voltage reference. However, the lowest voltage temperature-compensated zener is 6.2V. This makes it inconvenient to obtain a zero temperature-coefficient reference when the operating supply voltage is 6V or lower. With the availability of the LM113, this problem no longer exists.

The LM113 is a 1.2V temperature compensated shunt regulator diode. The reference is synthesized using transistors and resistors rather than a breakdown mechanism. It provides extremely tight regulation over a wide range of operating currents in addition to unusually low breakdown voltage and low temperature coefficient.

DESIGN CONCEPTS

The reference in the LM113 is developed from the highly-predictable emitter-base voltage of integrated transistors. In its simplest form, the voltage is equal to the energy-band-gap voltage of the semiconductor material. For silicon, this is 1.205V. Further, the output voltage is well determined in a production environment.

A simplified version of this reference¹ is shown in *Figure 1*. In this circuit, Q₁ is operated at a relatively high current density. The current density of Q₂ is about ten times lower, and the emitter-base voltage differential (ΔV_{BE}) between the two devices appears across R₃. If the transistors have high current gains, the voltage across R₂ will also be proportional to ΔV_{BE} . Q₃ is a gain stage that will regulate the output at a voltage equal to its emitter base voltage plus the drop across R₂. The emitter base voltage of Q₃ has a negative temperature coefficient while the ΔV_{BE} component across R₂ has a positive temperature coefficient. It will be shown that the output voltage will be temperature compensated when the sum of the two voltages is equal to the energy-band-gap voltage.

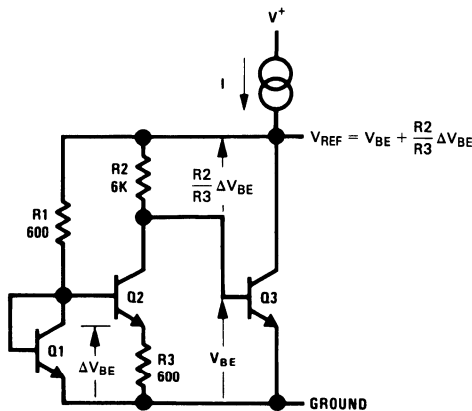


FIGURE 1. The Low Voltage Reference
in One of Its Simpler Forms

TL/H/7370-1

Conditions for temperature compensation can be derived starting with the equation for the emitter-base voltage of a transistor which is²

$$V_{BE} = V_{g0} \left(1 - \frac{T}{T_0} \right) + V_{BE0} \left(\frac{T}{T_0} \right) + \frac{nkT}{q} \log_e \frac{T_0}{T} + \frac{kT}{q} \log_e \frac{I_C}{I_{C0}} \quad (1)$$

where V_{g0} is the extrapolated energy-band-gap voltage for the semiconductor material at absolute zero, q is the charge of an electron, n is a constant which depends on how the transistor is made (approximately 1.5 for double-diffused, NPN transistors), k is Boltzmann's constant, T is absolute temperature, I_C is collector current and V_{BE0} is the emitter-base voltage at T_0 and I_{C0} .

The emitter-base voltage differential between two transistors operated at different current densities is given by

$$\Delta V_{BE} = \frac{kT}{q} \log_e \frac{J_1}{J_2} \quad (2)$$

where J is current density.

Referring to Equation (1), the last two terms are quite small and are made even smaller by making I_C vary as absolute temperature. At any rate, they can be ignored for now because they are of the same order as errors caused by non-theoretical behavior of the transistors that must be determined empirically.

If the reference is composed of V_{BE} plus a voltage proportional to ΔV_{BE} , the output voltage is obtained by adding (1) in its simplified form to (2):

$$V_{ref} = V_{g0} \left(1 - \frac{T}{T_0} \right) + V_{BE0} \left(\frac{T}{T_0} \right) + \frac{kT}{q} \log_e \frac{J_1}{J_2} \quad (3)$$

Differentiating with respect to temperature yields

$$\frac{\partial V_{ref}}{\partial T} = -\frac{V_{g0}}{T_0} + \frac{V_{BE0}}{T_0} + \frac{k}{q} \log_e \frac{J_1}{J_2} \quad (4)$$

For zero temperature drift, this quantity should equal zero, giving

$$V_{g0} = V_{BE0} + \frac{kT_0}{q} \log_e \frac{J_1}{J_2} \quad (5)$$

The first term on the right is the initial emitter-base voltage while the second is the component proportional to emitter-base voltage differential. Hence, if the sum of the two are equal to the energy-band-gap voltage of the semiconductor, the reference will be temperature-compensated.

Figure 2 shows the actual circuit of the LM113. Q₁ and Q₂ provide the ΔV_{BE} term and Q₄ provides the V_{BE} term as in the simplified circuit. The additional transistors are used to decrease the dynamic resistance, improving the regulation of the reference against current changes. Q₃ in conjunction with current inverter, Q₅ and Q₆, provide a current source load for Q₄ to achieve high gain.

Q₇ and Q₉ buffer Q₄ against changes in operating current and give the reference a very low output resistance. Q₈ sets the minimum operating current of Q₇ and absorbs any leak-

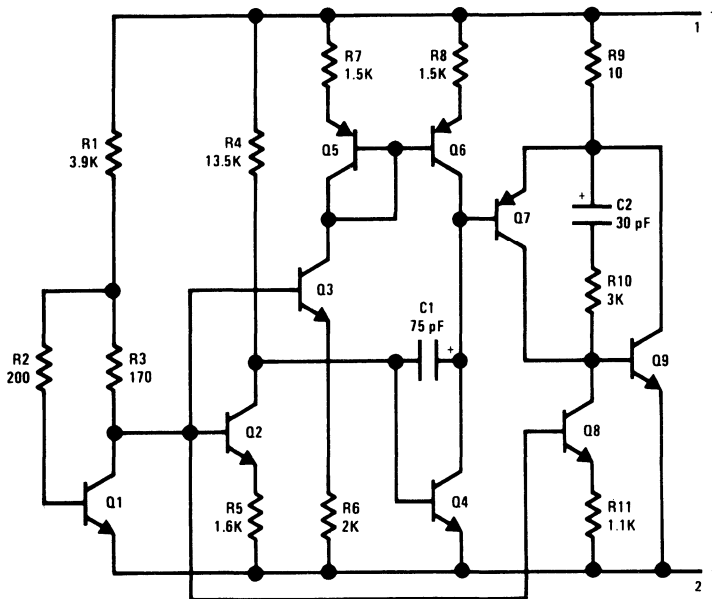


FIGURE 2. Schematic of the LM113

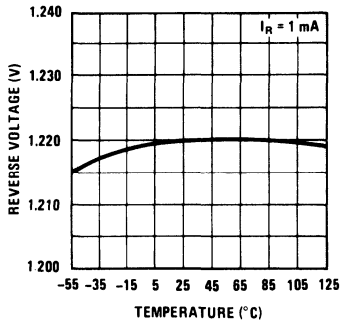
TL/H/7370-2

age from Q₉. Capacitors C₁, C₂ and resistors R₉ and R₁₀ frequency compensate the regulator diode.

PERFORMANCE

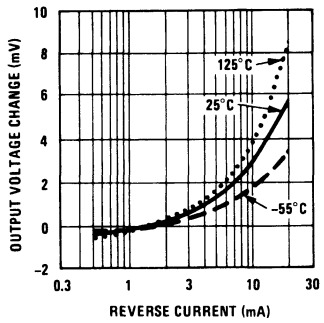
The most important features of the regulator diode are its good temperature stability and low dynamic resistance. Figure 3 shows the typical change in output voltage over a -55°C to +125°C temperature range. The reference voltage changes less than 0.5% with temperature, and the temperature coefficient is relatively independent of operating current.

Figure 4 shows the output voltage change with operating current. From 0.5 mA to 20 mA there is only 6 mV of change. A good portion of the output voltage change is due to the resistance of the aluminum bonding wires and the Kovar leads on the package. At currents below about 0.3 mA the diode no longer regulates. This is because there is insufficient current to bias the internal transistors into their active region. Figure 5 illustrates the breakdown characteristic of the diode.



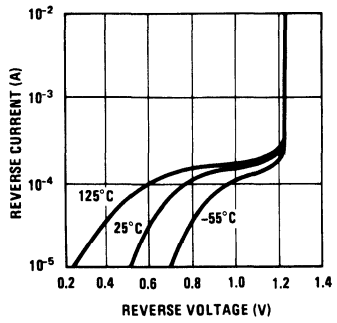
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FIGURE 3. Output Voltage Change with Temperature



TL/H/7370-4

FIGURE 4. Output Voltage Change with Current



TL/H/7370-5

FIGURE 5. Reverse Breakdown Characteristics

APPLICATIONS

The applications for zener diodes are so numerous that no attempt to delineate them will be made. However, the low

breakdown voltage and the fact that the breakdown voltage is equal to a physical property of silicon—the energy band gap voltage—makes it useful in several interesting applications. Also the low temperature coefficient makes it useful in regulator applications—especially in battery powered systems where the input voltage is less than 6V.

Figure 6 shows a 2V voltage regulation which will operate on input voltages of only 3V. An LM113 is the voltage reference and is driven by a FET current source, Q₁. An operational amplifier compares a fraction of the output voltage with the reference. Drive is supplied to output transistor Q₂ through the V⁺ power lead of the operational amplifier. Pin 6 of the op amp is connected to the LM113 rather than the output since this allows a lower minimum input voltage. The dynamic resistance of the LM113 is so low that current changes from the output of the operational amplifier do not appreciably affect regulation. Frequency compensation is accomplished with both the 50 pF and the 1 μF output capacitor.

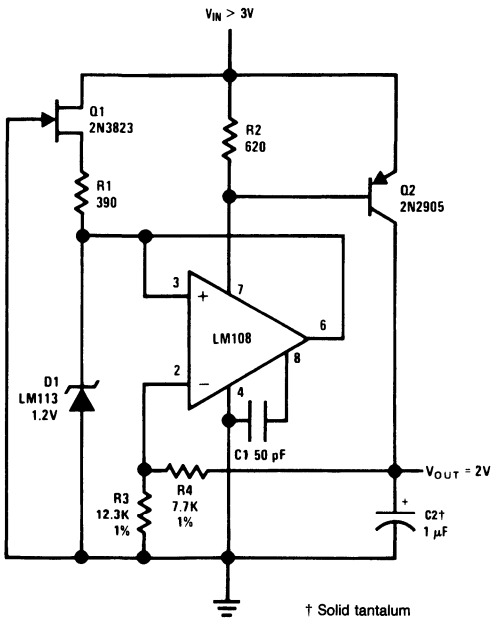


FIGURE 6. Low Voltage Regulator Circuit

It is important to use an operational amplifier with low quiescent current such as an LM108. The quiescent current flows through R₂ and tends to turn on Q₂. However, the value shown is low enough to insure that Q₂ can be turned off at worst case condition of no load and 125°C operation.

Figure 7 shows a differential amplifier with the current source biased by an LM113. Since the LM113 supplies a reference voltage equal to the energy band gap of silicon, the output current of the 2N2222 will vary as absolute temperature. This compensates the temperature sensitivity of the transconductance of the differential amplifier making the gain temperature stable. Further, the operating current is

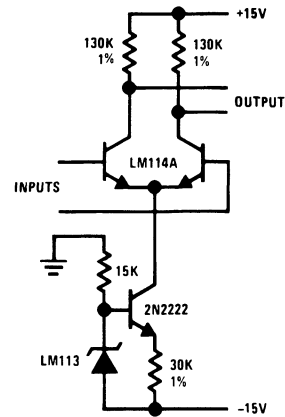


FIGURE 7. Amplifier Biasing for Constant Gain with Temperature

regulated against supply variations keeping the gain stable over a wide supply range.

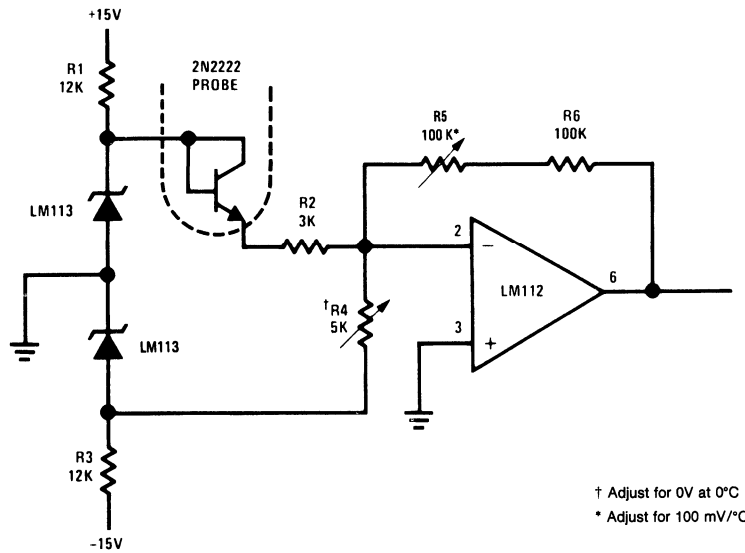
As shown, the gain will change less than two per cent over a -55°C to +125°C temperature range. Using the LM114A monolithic transistor and low drift metal film resistors, the amplifier will have less than 2 μV/°C voltage drift. Even lower drift may be obtained by unbalancing the collector load resistors to null out the initial offset. Drift under nulled condition will be typically less than 0.5 μV/°C.

The differential amplifier may be used as a pre-amplifier for a low-cost operational amplifier such as an LM101A to improve its voltage drift characteristics. Since the gain of the operational amplifier is increased by a factor of 100, the frequency compensation capacitor must also be increased from 30 pF to 3000 pF for unity gain operation. To realize low voltage drift, care must be taken to minimize thermoelectric potentials due to temperature gradients. For example, the thermoelectric potential of some resistors may be more than 30 μV/°C, so a 1°C temperature gradient across the resistor on a circuit board will cause much larger errors than the amplifier drift alone. Wirewound resistors such as Evenohm are a good choice for low thermoelectric potential.

Figure 8 illustrates an electronic thermometer using an inexpensive silicon transistor as the temperature sensor. It can provide better than 1°C accuracy over a 100°C range. The emitter-base turn-on voltage of silicon transistors is linear with temperature. If the operating current of the sensing transistor is made proportional to absolute temperature the nonlinearity of emitter-base voltage can be minimized. Over a -55°C to 125°C temperature range the nonlinearity is less than 2 mV or the equivalent of 1°C temperature change.

An LM113 diode regulates the input voltage to 1.2V. The 1.2V is applied through R₂ to set the operating current of the temperature-sensing transistor.

Resistor R₄ biases the output of the amplifier for zero output at 0°C. Feedback resistor R₅ is then used to calibrate the output scale factor to 100 mV/°C. Once the output is zeroed, adjusting the scale factor does not change the zero.



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FIGURE 8. Electronic Thermometer

CONCLUSION

A new two terminal low voltage shunt regulator has been described. It is electrically equivalent to a temperature-stable 1.2V breakdown diode. Over a -55°C to 125°C temperature range and operating currents of 0.5 mA to 20 mA the LM113 has one hundred times better reverse characteristics than breakdown diode. Additionally, wideband noise and long term stability are good since no breakdown mechanism is involved.

The low temperature coefficient and low regulation voltage make it especially suitable for a low voltage regulator or battery operated equipment. Circuit design is eased by the

fact that the output voltage and temperature coefficient are largely independent of operating current. Since the reference voltage is equal to the extrapolated energy-band-gap of silicon, the device is useful in many temperature compensation and temperature measurement applications.

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New Design Techniques for FET Op Amps

National Semiconductor
Application Note 63

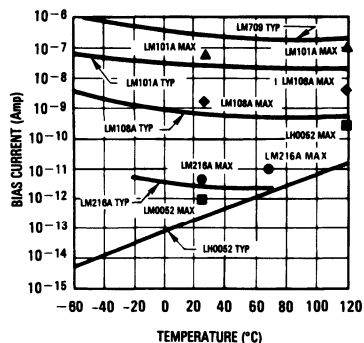


INTRODUCTION

The LH0052, LH0042 and LH0022 series operational amplifiers are "monobrid" integrated circuits consisting of a monolithic dual junction field effect transistor followed by a special linear integrated circuit amplifier chip. Each device features very closely matched input characteristics, very high input impedance, and ultra low input currents with no compromise in noise, common mode rejection ratio, open loop gain or slew rate. The LH0052 is internally laser nulled and features offset current of 100 femtoamps max at 25°C (100 pA at +125°C), offset voltage of 100 microvolts max and offset drift of 5 $\mu\text{V}/^\circ\text{C}$ max. Unlike most module FET op amps, this series of op amps does not require "grading" of electrical performance at final test. Different die types are used in each member of the family to assure availability and lowest possible cost. The amplifiers are internally compensated to be unity gain stable and require no external parts for operation with the exception of feedback and input impedances as dictated by the application. Amplifiers are available in TO-99, (TO-5 metal can) or 14-lead cavity dual-in-line package and are specified either for the full military temperature range of -55°C to $+125^\circ\text{C}$ or for an expanded commercial temperature range of -25°C to $+85^\circ\text{C}$. Operation is specified for power supply voltages between 10V ($\pm 5\text{V}$) and 44V ($\pm 22\text{V}$). Table I below, and Typical Performance Characteristics (last page) give a summary of other major parameters illustrating similarities and differences of members of the series. See individual data sheets for complete specifications.

WHY FETs?

The virtue of super gain bipolar transistors as the input stage to operational amplifiers is well known^{1,2} and widely used in such amplifiers as the LM108, LM112, and LM216. These amplifiers attain very low input bias currents by special processing that allows the first stage to run at very low emitter currents while achieving current gains of 1500. This results in relatively constant bias and offset currents with temperature tending to increase at low temperatures where transistor gain is lowest. (Figure 1.)



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FIGURE 1. Typical I_b vs. Temperature for Several Op Amps

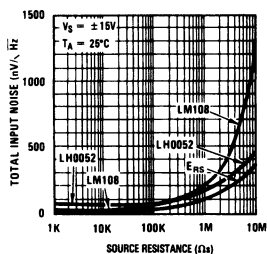
TABLE I. Performance Comparison of LH0052/LH0022/LH0042 FET Op Amp Family

Parameter ($T_A = 25^\circ\text{C}$)	LH0052	LH0022	LH0042	Units
Offset Voltage (Max)	0.5	4	20	mV
Offset Voltage Drift (Typ)	2	5	5	$\mu\text{V}/^\circ\text{C}$
Offset Current (Max)	2.5	2.0	5.0	pA
Bias Current (Max)	1.0	10	25	pA
Open Loop Gain (Min)	100	100	50	V/mV
Bandwidth (Typ)	1	1	1	MHz
Slew Rate (Typ)	3	3	3	V/ μs
Output Current Drive (Min)	± 10	± 10	± 10	mA
Min Supply Voltage	± 5	± 5	± 5	V
Max Supply Voltage	± 22	± 22	± 22	V
Input Voltage Range (Min)	± 12	± 12	± 12	V
CMRR (Min)	80	80	70	dB
Compensation Components	0	0	0	
Output Current Limit	Yes	Yes	Yes	
Simple Offset Null	Yes	Yes	Yes	
Package Types	TO-5	DIP, TO-5	DIP, TO-5	

The low emitter current available in the typical super gain amplifier severely limits the slew rate attainable, the devices that have input currents in the same area as the LH0052 family normally have slew rates in the neighborhood of a few tenths of a volt per microsecond. As long as a FET is operated in its normal linear region, its input current is not materially affected by the channel current. The LH0052 family, therefore, runs more input stage current and thus attains a typical slew rate of three volts per microsecond. A soon-to-be announced device (LH0062) has demonstrated slew rates greater than 50 V per μ s with the same input characteristics as the LH0052 family.

FET'S FEATURE SUPERIOR NOISE AT HIGH SOURCE RESISTANCES

Figure 2 is a plot of total amplifier noise at 100 Hz (1 Hz bandwidth) vs source resistance for the LH0052 family of FET amplifiers and the LM108, representative of the best super-gain bipolar amplifiers. Thermal noise contributed by the source resistance is also plotted. Note that at low source resistances the LM108 is lower noise; at high source resistance the LH0052 series is superior.



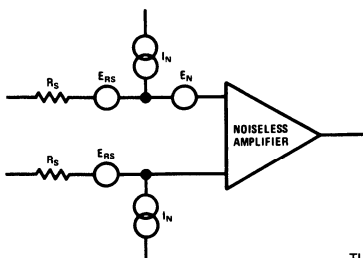
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FIGURE 2. Total Equivalent Input Noise Voltage

A useful noise model applicable to operational amplifiers in general is shown in Figure 3. It consists of an ideal noiseless amplifier preceded by a number of noise sources. Amplifier voltage noise, E_N , appears directly in series with one of the inputs. Current noise from the amplifier develops an additional noise voltage across the source resistance. The RMS value of thermal noise from the source resistances can be calculated from the equation $E_{TS} = \sqrt{4kT(BW)R_S}$ which simplifies to $E_{TS} = \sqrt{R_S}$ nV/ $\sqrt{\text{Hz}}$ for room temperature calculations and resistor values in k Ω .

The total spot noise present at the input to the ideal amplifier may be found by summing the RMS values of the three noise voltage sources as follows:

$$E_T = \sqrt{E_N^2 + 2(R_S I_N)^2 + 2E_{TS}^2}$$



TL/H/8746-3

FIGURE 3. Noise Model of an Operational Amplifier

E_N comes directly from data of the type plotted in the figure by looking at the flat portion of the curve below 10k and assuming that the current noise is insignificant in this area. For the LH0052 and LM108 E_N , at 100 Hz, 1 Hz bandwidth, is 70 nV/ $\sqrt{\text{Hz}}$ and 35 nV/ $\sqrt{\text{Hz}}$ respectively. I_N may be computed from a total noise measurement at high source resistance by using a calculated value of E_{TS} and the previously measured value of E_N .

$$I_N = \sqrt{(E_T^2 - E_N^2 - 2E_{TS}^2)/2R_S^2}$$

For the LH0052 family and the LM108, I_N is 10 fA/ $\sqrt{\text{Hz}}$ and 100 fA/ $\sqrt{\text{Hz}}$ respectively.

One way to illustrate the importance of noise current in deciding which of two amplifier types will be better in a given situation is to set the total noise equal for the two cases and solve for the value R_S at which this occurs. The amplifier with the lower noise voltage will be superior at source resistances lower than this value; the one with lower current noise will be better at higher resistances. Note that this is merely calculating the intersection of the curves of Figure 2. The intersection will normally lie near 150k when comparing the LH0052 family with the best of the presently available bipolar amplifiers.

LOW OFFSET VOLTAGE IS NO PROBLEM WITH MODERN JFETs

FETs have a reputation for poor control of voltage matching characteristics that developed from behavior of the early matched dual discrete devices. These were invariably a pair of separate FET chips mounted on the same header tested for gate to source voltage match at some specified current at room temperature. Devices constructed in this manner tracked rather poorly over temperature due to G_{FS} mismatch and temperature gradients across the header.

The monolithic dual FETs of the FM1100 series interweave the channels of the two halves of the device and achieve a match not only of V_{GS} but of all other parameters. Further, the V_{GS} match is preserved over a wide range of drain currents, drain to source voltage, and temperature. The voltage drift attainable with this technique is exceeded only by the very best bipolar devices.

It is possible to fabricate FETs and bipolar transistors on the same wafer at the same time. Why not build a single monolithic FET/bipolar amplifier utilizing each where it is best suited? It would seem at first glance that this would necessarily result in a cheaper, more reliable product. At the present state of the art, severe compromises are necessary to both the FET and bipolar devices so constructed as exemplified by the 740 and 536 with the net result that specifications must be relaxed and/or a yield loss suffered. The two chip "monobrid" approach taken with the LH0052 family maximizes performance while allowing lower cost.

CIRCUIT DESCRIPTION

Figure 4 is a simplified schematic typical of all of the amplifiers in the family. The input FET (Q_1, Q_2) is a monolithic dual similar in construction to the discrete FM1100 series device. The stage is operated as a source follower with V^+ applied directly to the drains for the maximum possible common mode range.

A differential common base PNP stage (Q_3, Q_4) serves as the load for the input FETs. The bases of this stage form the bias point for the backside gate of the monolithic input FET³. To obtain high voltage gain from the PNP common base stage, the output resistances of Q_5 and Q_6 are used

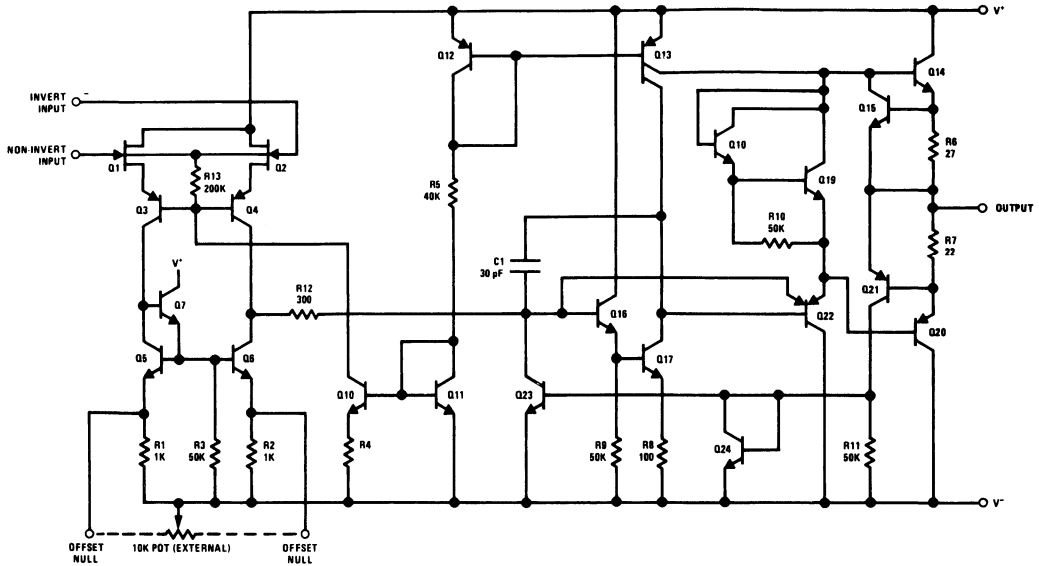


FIGURE 4. Internal Schematic

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as loads, giving effective values of about 2 mΩ while at the same time converting the differential current signal into a single ended voltage. The operating drain current for the input stage is determined by the bias network composed of the current source Q₁₀ and the diodes Q₁₁ and Q₁₂; target current is 40 μA per side.

A Darlington driver (Q₁₆, Q₁₇) is used to avoid loading the first stage output. The output stage uses a conventional complementary symmetry design with a bias current of about 60 μA through Q₁₄ to Q₂₀ to minimize crossover distortion. Output current is limited to about ±25 mA at 25°C ambient decreasing to about ±17 mA at +125°C. The output characteristics are similar to those of conventional amplifiers.

SIMPLE OFFSET VOLTAGE ADJUSTMENT DOES NOT DEGRADE DRIFT OF CMRR

These amplifiers use the same internal offset nulling technique as the LM741 and others, that is, a single 10k pot connected between the offset nulling pins and V⁻ as shown in Figure 5. Adjustment of this pot will always produce offset null. With the premium devices of the series, it may be desirable to restrict the range of adjustment to increase the precision of the null. This may be done by inserting a resistor of about 100k in series with the wiper of the pot. This technique provides a method of externally nulling offset voltage of the amplifiers to zero with virtually no effect on the offset voltage drift or CMRR.

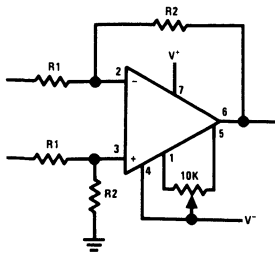
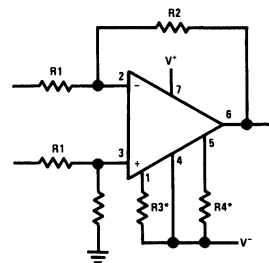


FIGURE 5. Trimpot Offset Trim

TL/H/8746-5



*R3 and/or R4 installed at calibration

FIGURE 6. Fixed Resistor Offset Trim

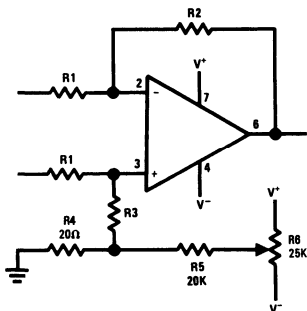
TL/H/8746-6

By definition, offset voltage is that voltage which must be applied between the input terminals to obtain zero output voltage. This suggests a straight-forward and practical "universal"¹⁴ system to null the offset in an operating circuit.

Figure 7 illustrates one way that an adjustable voltage in the millivolt range may be connected in series with the input signal to subtract the amplifier offset. If this technique of offset nulling at the inputs of the amplifier is used, the TO-5 devices of the series will be pin compatible with virtually all of the 8-pin TO-5 amplifiers on the market today, bipolar or FET.

CAREFUL PC BOARD LAYOUT MUST BE OBSERVED

In order to realize the full low input current capabilities of these amplifiers, considerable care must be exercised in the design of the input circuitry and in the selection of materials contacting the input conductors. A leakage impedance of even $10^{12}\Omega$ to 15V produces a leakage current of 15 pA, much higher than amplifier input current. This level of leakage may be inadvertently produced by socket leakage, poor quality or imperfectly cleaned printed circuit boards, or improperly cured protective coatings. Sockets are to be avoided if possible; they can not only degrade leakage current, but may cause other unsuspected erratic behavior when used in severe environments. (If absolutely unavoidable, they should be high quality, preferably Teflon.) Printed circuit board material should be judged both on initial resistivity and on the likelihood of degradation by outside influences. Teflon and polycarbonate are particularly recommended; glass epoxy may be used if it is protected with a silicone or epoxy coating to prevent moisture absorption. If operation at high humidities is required, this coating will be desirable anyway to control surface leakage. All residues of previous operations, such as soldering flux, inks, and resists, must of course be thoroughly removed before coating.



TL/H/8746-7

$$R2 = R3 + R4$$

$$\text{Adjustment Range} \approx [V^+ - V^-] \left(\frac{R5}{R4} \right) \left(\frac{R1}{R1 + R3} \right)$$

$$\text{Voltage Gain} = \frac{R2}{R1}$$

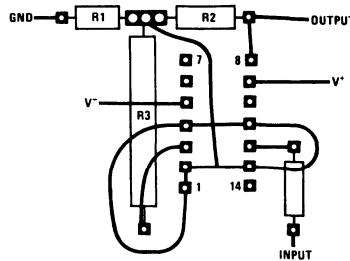
FIGURE 7. Universal Offset Trim

Another approach which has been successfully used with the TO-5 amplifiers is to terminate all critical connections on Teflon standoff insulators. These may be interconnected as required with Teflon insulated wire, keeping connections as short as possible to minimize noise pick-up. A short length of Teflon tubing slipped over the wire from the amplifier prevents contact with the oversize hole in the mounting board. The remainder of the amplifier connections may be terminated conventionally, either to printed circuit lands or to other standoff insulators.

INPUT GUARDING IMPROVES SYSTEM PERFORMANCE

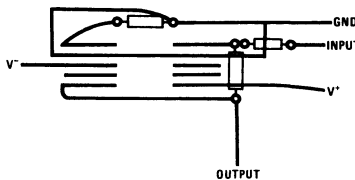
Even with properly cleaned and coated printed circuit boards, leakage currents can limit the circuit performance under severe environmental conditions. In most cases with the LH0052 family devices, leakage will be primarily to V^- as the inputs are between the offset null pin (which in normal operation runs at a voltage very near V^-) and the V^- pin itself. This would seem to predict that leakage into the inverting and non-inverting inputs should at least be of the same polarity, but the effects are too unpredictable to make much use of the cancellation which should occur.

These currents may be intercepted before they reach the amplifier inputs by a guard conductor in the leakage path operating at the same potential as the inputs. Resistance between the inputs and the guard will cause little current to flow because of the premise that the guard voltage equals the input voltage. Suggested board layouts for the various package types are shown in Figures 8 through 11.



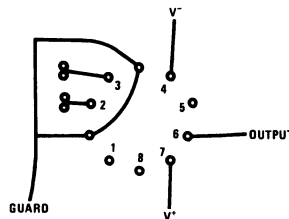
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FIGURE 8. DIP Non-Inverting Amplifier PC Layout



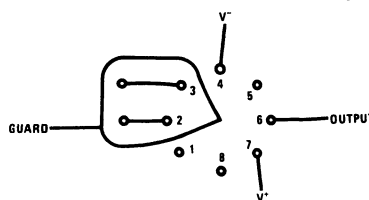
TL/H/8746-9

FIGURE 9. Flat Pack Inverting Amplifier PC Layout



TL/H/8746-10

FIGURE 10. TO-5—10 Pin Pattern PC Layout



TL/H/8746-11

FIGURE 11. TO-5—8 Lead Pattern

The flat pack and dual-in-line packages have an unconnected pin on either side of the inputs. These may be used as shown, both to continue the guard into the package and as a convenient method of surrounding the inputs with a guard conductor without running a line between device pins. The eight lead TO-5 package has only one spare pin, so the leads must either be formed into a 10 lead circle with two gaps, or the pin circle expanded sufficiently to allow a conductor to pass between device pins. If the board is double sided or multilayer, the guard pattern should be repeated on all conductor planes.

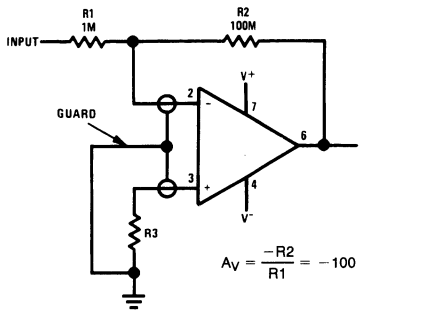


FIGURE 12. Guarded Inverting Amplifier

Figure 12 through 15 show how the guard is committed on the more common op amp circuits. With an integrator or inverting amplifier, where the inputs are close to the ground potential, the guard is simply grounded. With the voltage follower, the guard is bootstrapped to the output. If it is desirable to put a resistor in the inverting input to compensate for the source resistance, it is connected as shown in Figure 13.

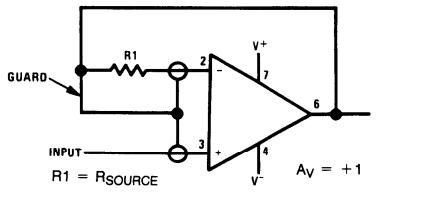


FIGURE 13. Guarded Voltage Follower

Guarding a non-inverting amplifier is a little more complicated. A low impedance point must be created by using relatively low value feedback resistors to determine the gain (R_1 and R_2 in Figure 14). The guard is then connected to the junction of the feedback resistors. Low impedance in this context means that expected leakage currents should not be capable of generating deleterious error voltages. A resistor, R_3 , may be added to balance the source resistance and thus cancel the effect of bias current.

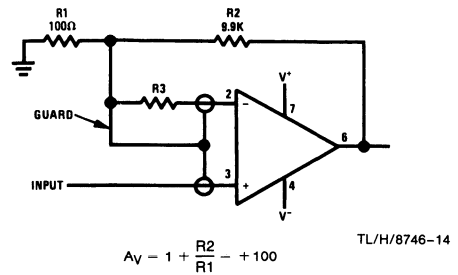


FIGURE 14. Guarded Non-Inverting Amplifier

The general case of a full differential configuration may require the use of a guard driver amplifier A_2 as shown in Figure 15. Resistors R_5 and R_6 develop the proper voltage for the guard at their junction, but it will normally be impractical to make them low enough resistance due to source loading. R_7 is included to balance the effect of R_5 plus R_6 and thus not degrade the closed loop common mode rejection.

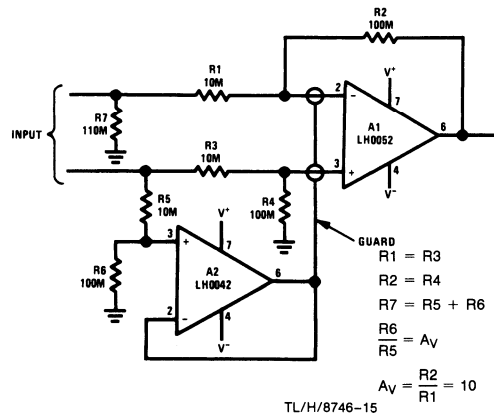


FIGURE 15. Guarded Full Differential Amplifier

VOLTAGE FOLLOWERS

The excellent common mode rejection and range of the amplifiers in this series suggest their use as unity gain voltage follower amplifiers. They perform well in this function with the one precaution shown on the circuit of Figure 16. The straightforward circuit with a direct feedback connection and no resistors will function, but if a low impedance signal having a slew rate faster than the amplifier can follow is applied to the input, a differential input voltage might be developed in excess of the absolute maximum. R_1 limits the current under these conditions to a safe value of $200 \mu A$. R_2 is included to cancel the error voltage due to bias current and should in general be equal to the source resistance plus R_1 .

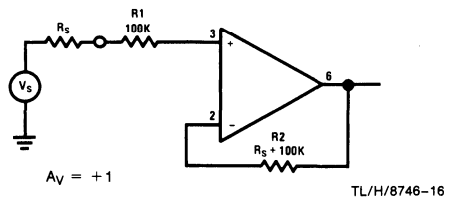


FIGURE 16. Unity Gain Voltage Follower

For applications requiring voltage gain as well as high input impedance, a voltage divider may be included in the feedback path as in *Figure 17*. The voltage gain of this circuit is approximately $1 + R_2/R_3$ (neglecting amplifier open loop gain).

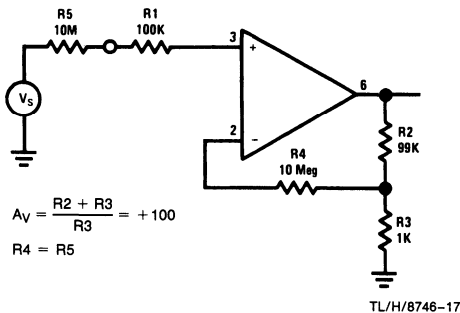


FIGURE 17. Non-Inverting Amplifier

R_4 is included as a convenient variable to equalize resistances in the two amplifier inputs: R_4 in series with the parallel combination of R_2 and R_3 should be set equal to the source resistance plus R_1 . Note that all of these resistors may not be necessary depending on the required voltage gain, source impedance, accuracy requirement, temperature range, and amplifier selected.

PRECISION INTEGRATOR

The low input bias currents attainable with amplifiers of this series make them a natural choice for integrator applications requiring long time constants. *Figure 18* illustrates a typical practical circuit. R_1 should be selected so that the total leakage current at the summing node is smaller than

the signal current (V_1/R_1) by a margin sufficient to insure the required accuracy, i.e., $V_1/R_1 \gg I_{b1}$. C_1 should be chosen for low leakage, stability, accuracy, and low voltage coefficient. Polystyrene or polycarbonate dielectric is the best choice for capacitances up to about $1 \mu\text{F}$. Teflon is good for the lower values.

R_2 is included to protect the input circuit during the reset transient, although many low speed applications will not require it at all. If the resistance of the reset switch is 100Ω , the maximum current that could flow in C_1 is $10\text{V}/100 = 0.1$ amp. In reality this may well be limited to a lower value by I_{DSS} , if the reset switch is an FET. Then the rate of change of voltage cannot exceed $0.1 \text{ amp}/1 \mu\text{F} = 0.1 \text{ V}/\mu\text{s}$ which is well within the slew rate capability of the amplifier. R_3 , used to balance the resistance in the inputs, should be made equal to the sum of R_2 and the reset switch resistance.

SAMPLE/HOLD AMPLIFIERS

The LH0052 family of amplifiers is well suited for use as a buffer amplifier in long hold-time sample/hold circuits. They may be used in any of the common configurations where improved hold performance is required. *Figure 19a* illustrates one circuit taking advantage of the low bias currents attainable. R_1 serves to bootstrap the connection between analog switch S_1 and S_2 so that there is essentially no voltage across S_1 in the hold mode. When S_1 and S_2 are closed to enter the sample mode, the effect of R_1 is slight as it is much higher resistance than the switches. After a long enough time, C_1 will charge to the input voltage, the amplifier will buffer it to the output, and both ends of R_1 will be at the input potential so it will have no effect at all after the transient. *Figure 19b* illustrates an alternate circuit configuration with input buffer amplifier.

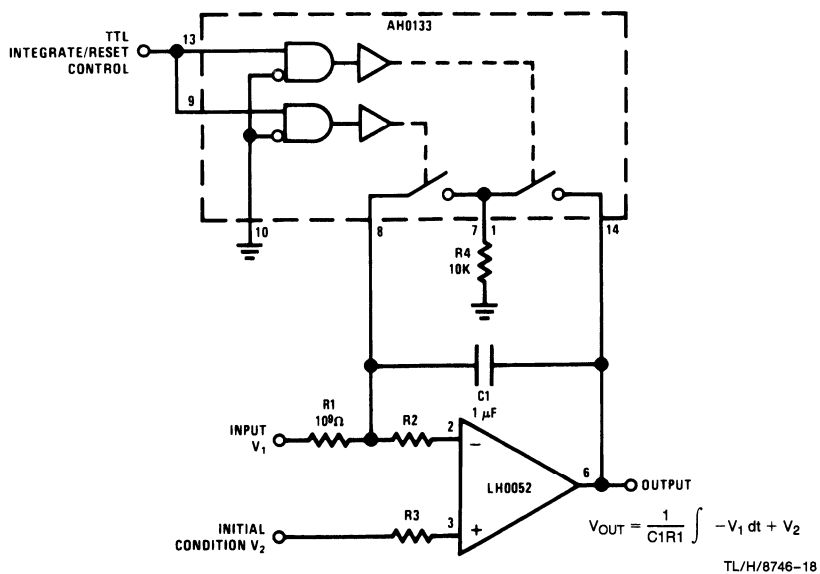


FIGURE 18. Precision Integrator

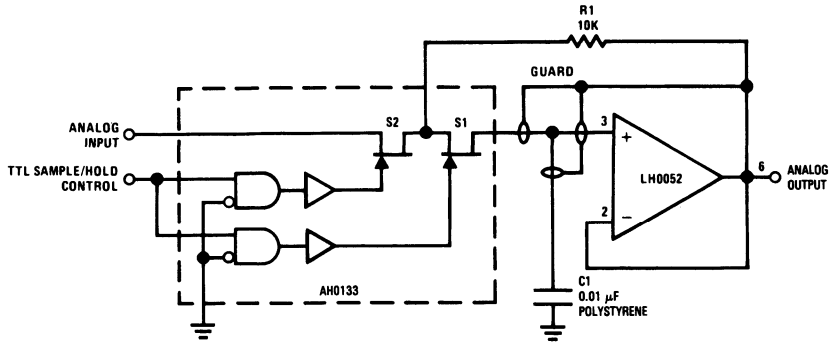


FIGURE 19a. Low Drift Sample/Hold

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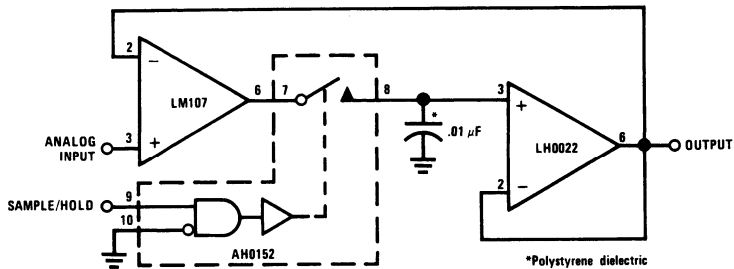


FIGURE 19b. Precision Sample and Hold

TL/H/8746-20

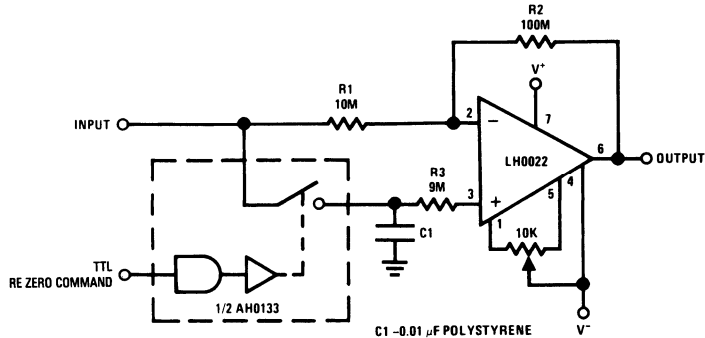


FIGURE 20. Re-Zeroing Amplifier

TL/H/8746-21

RE-ZEROING AMPLIFIER

Figure 20 illustrates a technique which may be useful in situations where a signal has an unknown and variable DC offset, such as in telemetry. In operation, the re-zero command line is enabled while a ground reference signal is applied to the input of the system. This causes C_1 to charge to a level proportional to the system DC offset. When the re-zero line is deactivated, the amplifier behaves like a conventional inverting stage, subtracting off the system offset and giving a true ground referenced output.

If the total worst case leakage at the capacitor node is 1 nA, and if $C_1 = 0.01 \mu\text{F}$, then the drift rate is $10^{-9}/0.01 \times 10^{-6} = 0.1 \text{ V/s}$. For a 10V full scale system requiring an accuracy of 0.1% (10 mV), the amplifier would need re-zeroing reference every 100 ms.

PRECISION CURRENT SINK

Figure 21 illustrates a variation on a common technique for generating a precisely regulated current. This circuit could be used in conjunction with another FET input amplifier connected as a high input impedance follower to form an ohmmeter for accurately measuring very high resistances. R_1 , R_2 and D_1 form bias and reference voltages near, but within, the common mode and output voltage limits of the amplifier. Q_1 is selected for very low gate leakage so that the current in its source will be nearly identical to the feedback current in its drain. In operation, the amplifier output will cause the gate of Q_1 to be cut off however much is necessary to keep the voltage across R_3 equal to 1.220V, the breakdown voltage of D_1 . The LM113 diode is available to an initial voltage accuracy of 1% (12.2 mV) and is guaran-

teed to drift less than 15 mV over the temperature range, thus by specifying the LH0052 amplifier and a 1% resistor, a current sink can be designed for a worst case initial accuracy near 2% and a drift over the temperature range of less than 2%. The technique may be applied over a wide range of currents by properly scaling R_3 and its balancing resistor R_4 ; a mirror image current source is possible using a P channel FET for Q_1 .

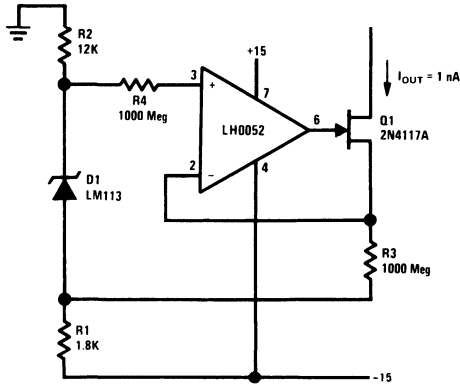


FIGURE 21. Precision Current Sink

TL/H/8746-22

PRECISION COMPARATOR

FET amplifiers have a significant advantage over bipolar in precision voltage comparator applications: the input current is nearly independent of input voltage. With a bipolar input stage, input current is $1/\beta$ of the emitter current, but the emitter current can vary from zero when the stage is cut off to twice the nominal value when fully conducting. Furthermore, the inputs are often internally clamped to a diode drop for protection of the emitter base junctions.

As long as the input and reference signals are no more than 4V apart in the circuit of *Figure 22*, the input currents remain low and constant. This is an adequate signal range for many applications, especially in view of the offset voltage performance available in the top of the line amplifiers. If wider signal range is required, resistors R_1 and R_2 should be included to limit the input current to a safe value. Internal zener junctions will limit the differential input voltage to a safe value if the input current is limited 200 μ A.

The output clamp circuit shown in *Figure 22* will drive 3 standard TTL loads or 30 National low power TTL loads. Considerable power may be saved by increasing R_3 if full fan-out is not required. If only 2 low power loads are to be driven, the required low state output current is 360 μ A, so $R_3 = 10V/360 \mu A = 27k$.

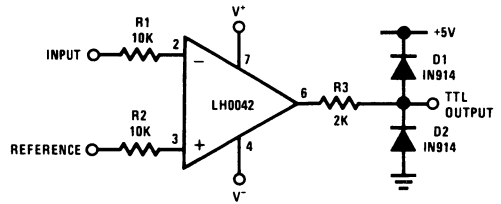


FIGURE 22. Precision Voltage Comparator

TL/H/8746-23

TRUE INSTRUMENTATION AMPLIFIER

Figure 23a illustrates an instrumentation amplifier that features high differential and common mode input resistance ($10^{12}\Omega$), $\pm 10V$ common mode and differential mode input range, 0.01% gain accuracy at $A_V = 1000$, and 110 dB CMRR with 1 k Ω imbalance in bridge source resistance. Input current is less than 1 pA and offset drift is less than 5 $\mu V/^\circ C$. R_1 provides a simple means of adjusting gain over a wide range without degrading CMRR. R_2 is an initial trim used to maximize CMRR without using super precision

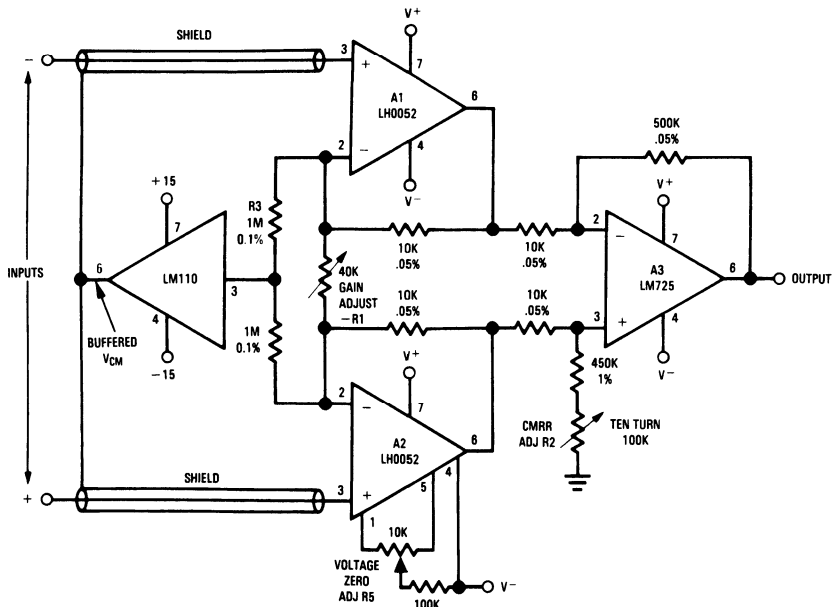


FIGURE 23a. True Instrumentation Amplifier

TL/H/8746-24

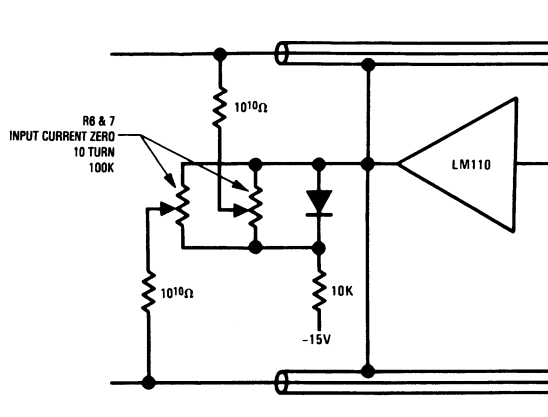


FIGURE 23b. Zero Input Bias Current

TL/H/8746-25

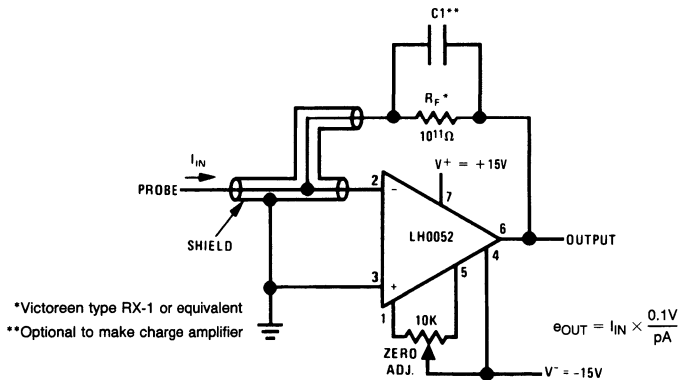


FIGURE 24. Picoamp Amplifier

TL/H/8746-26

matched resistors. Input common voltage is sensed via R_3 and R_4 and the LM110 provides low impedance V_{CM} drive to input cable shields to reduce leakage and coupling to inputs. If the input current of the LH0052 (1 pA max) is not low enough, additional circuitry as shown in *Figure 23b* may be added to provide "Zero" input bias current.

ULTRA LOW LEVEL TRANSCONDUCTANCE OR CHARGE AMPLIFIER

A picoamp amplifier for pH meters, medical electronics and radiation detectors is illustrated in *Figure 24*. A high quality glass sealed feedback resistor such as Victoreen type RX-1 should be employed as well as guard shielding as discussed earlier. Optionally C_1 may be added to convert the circuit to a charge amplifier with R_L used to provide DC stability.

PRECISION SUBTRACTOR FOR AUTOMATIC TEST GEAR

It is often necessary in testing linear circuits to take the difference between two voltage readings occurring at different times. The specialized sample/hold circuit shown in *Figure 25* performs this function simply and accurately. Initially, S_1 and S_2 are closed and S_3 open with the logic input in the TTL "1" state. This allows capacitor C_1 to charge to the

same voltage as the e_{IN1} input signal. When the logic input is taken to TTL "0", S_1 and S_2 open and S_3 closes, causing the difference between the stored value of e_{IN1} and the present value of e_{IN2} to appear at the non-inverting input of the LH0022.

The low leakage and high input impedance of the LH0022 allows the use of a reasonable size hold capacitor while at the same time providing gain for scaling, if needed. Note that the two analog inputs, e_{IN1} and e_{IN2} may be connected together to take the voltage difference on a single line at two different times. The disable input is used to open all switches, for example, to ignore a transient. If not needed, the disable input should be grounded.

SENSITIVE LOW COST "VTVM"

Figure 26 illustrates a modern approach to constructing VTVM's and VOM's. The LH0042 replaces all active circuitry. Optionally the circuit may be run off of 8 flashlight batteries and only draws 20 mW of power. The clever designer would add some more switching to allow operation of the FET op amp in transconductance mode as shown in *Figure 24*, thus combining both voltage and current measuring capability into the same circuit.

HOW TO BUILD A FET OP AMP "MODULE"

The LH0052 series when compared spec for spec with modules usually offers superior performance and significantly lower cost. What's the difference between modules and these integrated circuit amplifiers? In most cases the answer is nothing but two 0.01 μ F power supply decoupling capacitors. To make your own module merely build a small

1 1/4 x 1 1/4 printed circuit board that adapts the pin-out of the LH0052 to your module requirement. No need to pot the assembly in epoxy, the LH0052 family is completely hermetic and does not absorb moisture. Some modules specify higher output current capability than the ± 10 mA of the LH0052. To build a ± 100 mA output "module" FET op amp, simply add a LH0002 buffer as shown in *Figure 27*.

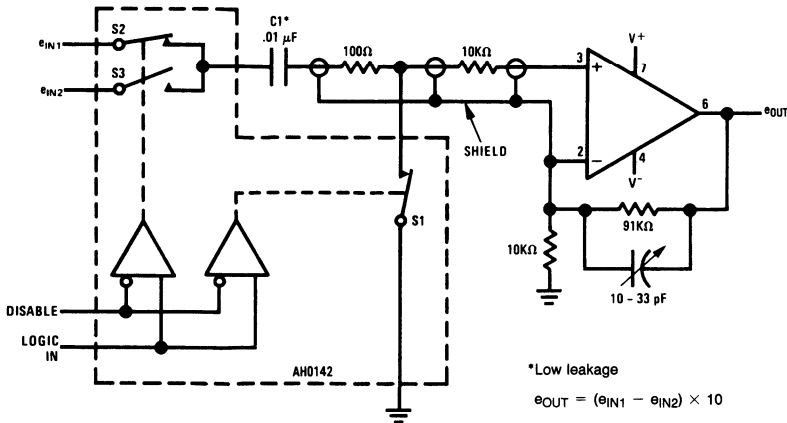


FIGURE 25. Precision Subtractor for Automatic Test Gear

TL/H/8746-27

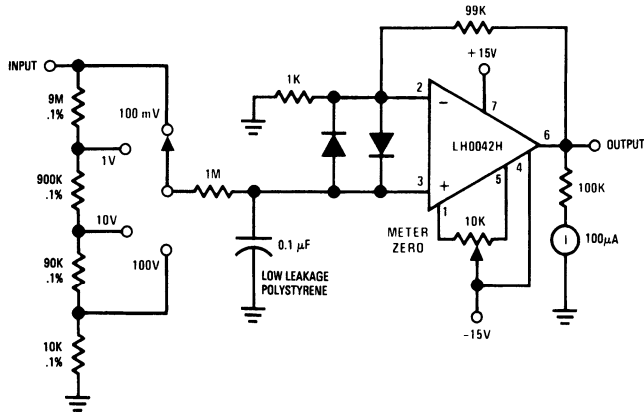


FIGURE 26. Sensitive Low Cost "VTVM"

TL/H/8746-28

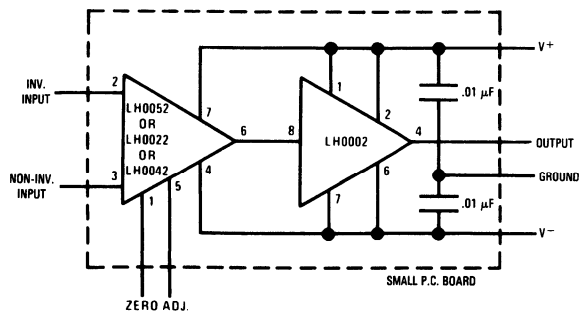
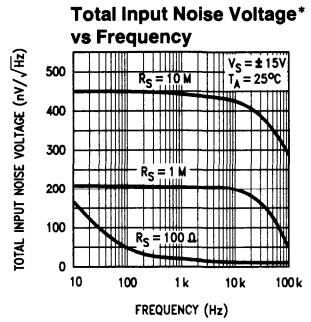
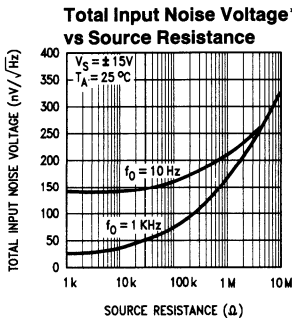
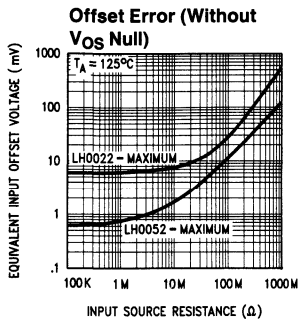
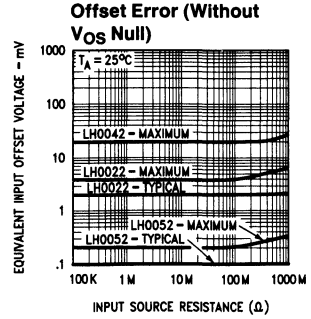
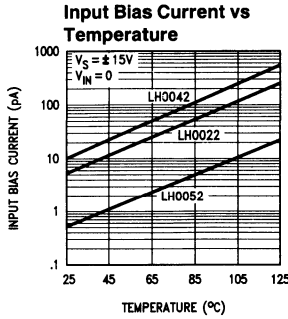
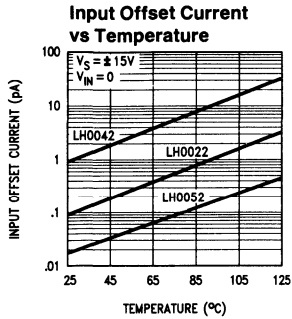


FIGURE 27. 100 mA Output FET Op Amp "Module"

TL/H/8746-29

Typical Performance Characteristics

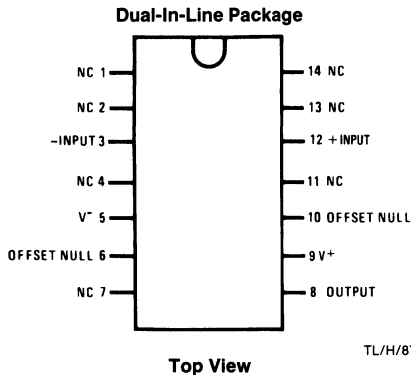


*Noise Voltage Includes Contribution from Source Resistance

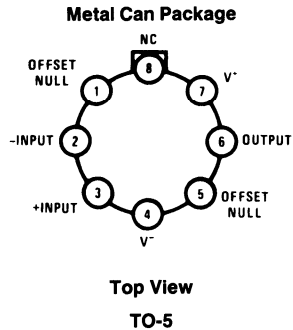
*Noise Voltage Includes Contribution from Source Resistor

TL/H/8746-30

Connection Diagrams



TL/H/8746-31



TL/H/8746-32

CONCLUSION

The practical advantages of the LH0052 series of FET input operational amplifiers has been demonstrated. The extremely low input bias and offset current make members of the family ideal choices for critical applications in hold amplifiers, active filters and instrumentation. The low input offset voltage and drift, high open loop gain, and excellent common mode rejection combine to make the devices equally well suited for general purpose applications including summers, subtractors, and oscillators.

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LM381 Low Noise Dual Preamplifier

National Semiconductor
Application Note 64



AN-64

INTRODUCTION

The LM381 is a dual preamplifier expressly designed to meet the requirements of amplifying low level signals in low noise applications. Total equivalent input noise is typically $0.5 \mu\text{Vrms}$ ($R_S = 600\Omega$, 10–10, 000 Hz).

Each of the two amplifiers is completely independent, with an internal power supply decoupler-regulator, providing 120 dB supply rejection and 60 dB channel separation. Other outstanding features include high gain (112 dB), large output voltage swing ($V_{CC} - 2V$) p-p, and wide power bandwidth (75 kHz, 20 V_{p-p}). The LM381 operates from a single supply across the wide range of 9V to 40V. The amplifier is internally compensated and short-circuit protected.

Attempts have been made to fill this function with selected operational amplifiers. However, due to the many special requirements of this application, these recharacterizations have not adequately met the need.

With the low output level of magnetic tape heads and phonograph cartridges, amplifier noise becomes critical in achieving an acceptable signal-to-noise ratio. This is a major deficiency of the op amp in this application. Other inadequacies of the op amp are insufficient power supply rejection, limited small-signal and power bandwidths, and excessive external components.

TABLE 1. $T_A = 25^\circ\text{C}$, $V_{CC} = 14V$, unless otherwise stated.

Parameter	Conditions	Min	Typ	Max	Units
Voltage Gain	Open Loop (Differential Input)		160,000		V/V
	Open Loop (Single Ended Input)		320,000		V/V
Supply Current	V_{CC} 9V to 40V, $R_L = \infty$		10		mA
Input Resistance (Positive Input) (Negative Input)			100		k Ω
			200		k Ω
Input Current (Positive Input) (Negative Input)			0.2		μA
			0.5		μA
Output Resistance	Open Loop		150		Ω
Output Current	Source Sink		8		mA
			2		mA
Output Voltage Swing	Peak-To-Peak		$V_{CC} - 2$		V
Small Signal Bandwidth			15		MHz
Power Bandwidth	20 V_{p-p} ($V_{CC} = 24V$)		75		kHz
Maximum Input Voltage	Linear Operation			300	mVrms
Supply Rejection Ratio	$f = 1$ kHz		120		dB
Channel Separation	$f = 1$ kHz		60		dB
Total Harmonic Distortion	75 dB Gain, $f = 1$ kHz		0.1		%
Total Equivalent Input Noise	$R_S = 600\Omega$, 10–10, 000 Hz (Single Ended Input)		0.55		μVrms
Noise Figure	50 k Ω , 10–10, 000 Hz } 10 k Ω , 10–10, 000 Hz } 5 k Ω , 10–10, 000 Hz } (Single Ended Input)		1.0		dB
			1.3		dB
			1.6		dB

CIRCUIT DESCRIPTION

To achieve low noise performance, special consideration must be taken in the design of the input stage. First, the input should be capable of being operated single ended; since both transistors contribute noise in a differential stage degrading input noise by the factor $\sqrt{2}$. Secondly, both the load and biasing elements must be resistive; since active components would each contribute as much noise as the input device.

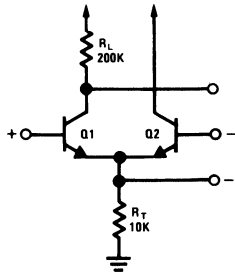


FIGURE 1. Input Stage

TL/H/7376-1

The basic input stage, *Figure 1*, can operate as a differential or single ended amplifier. For optimum noise performance Q_2 is turned OFF and feedback is brought to the emitter of Q_1 .

In applications where noise is less critical, Q_1 and Q_2 can be used in the differential configuration. This has the advantage of higher impedance at the feedback summing point, allowing the use of larger resistors and smaller capacitors in the tone control and equalization networks.

The voltage gain of the single ended input stage is given by:

$$A_{V(AC)} = \frac{R_L}{r_e} = \frac{200k}{1.25k} = 160 \quad (1)$$

Where:

$$r_e = \frac{KT}{qI_E} \approx 1.25 \times 10^3 \text{ at } 25^\circ\text{C } I_E \approx 20 \mu\text{A}$$

The voltage gain of the differential input stage is:

$$A_V = \frac{1}{2} \frac{R_L}{r_e} = \frac{1}{2} \frac{R_L q I_E}{KT} \approx 80 \quad (2)$$

The schematic diagram of the LM381, *Figure 2*, is divided into separate groups by function; first and second voltage gain stages, third current gain stage, and the bias regulator.

The second stage is a common-emitter amplifier (Q_5) with a current source load (Q_6). The Darlington emitter-follower Q_3, Q_4 provides level shifting and current gain to the common-emitter stage (Q_5) and the output current sink (Q_7). The voltage gain of the second stage is approximately 2000, making the total gain of the amplifier typically 160,000 in the differential input configuration.

The preamplifier is internally compensated with the pole-splitting capacitor, C_1 . This compensates to unity gain at 15 MHz. The compensation is adequate to preserve stability to a closed loop gain of 10. Compensation for unity gain closure may be provided with the addition of an external capacitor in parallel with C_1 between Pins 5 and 6, 10 and 11.

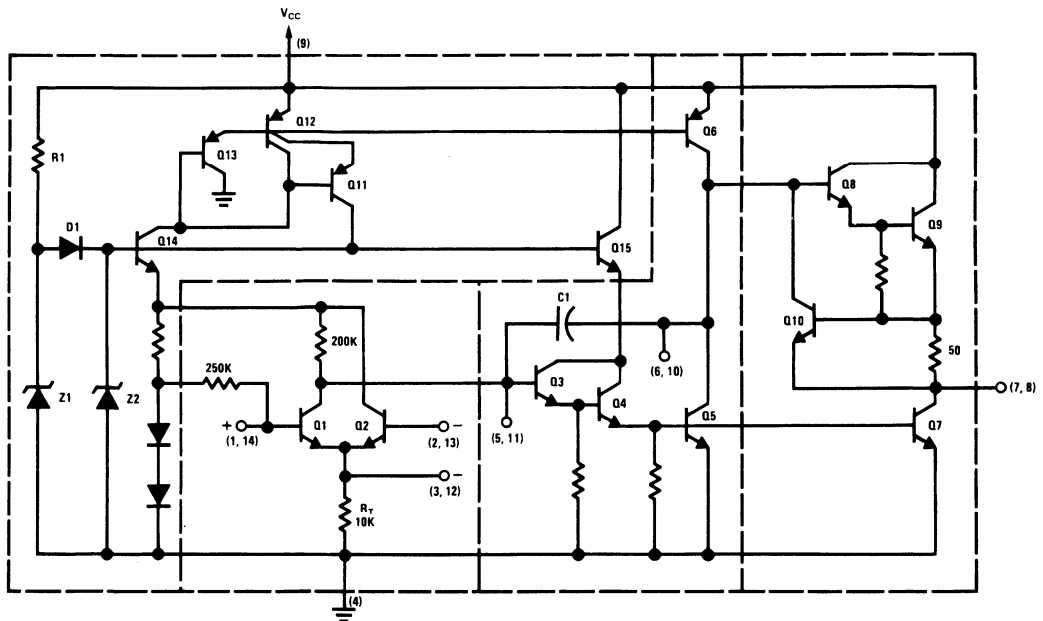


FIGURE 2. Schematic Diagram

TL/H/7376-2

Three basic compensation schemes are possible for this amplifier: first stage pole, second stage pole and pole-splitting. First stage compensation will cause an increase in high frequency noise because the first stage gain is reduced, allowing the second stage to contribute noise. Second stage compensation causes poor slew rate (power bandwidth) because the capacitor must swing the full output voltage. Pole-splitting overcomes both these deficiencies and has the advantage that a small monolithic compensation capacitor can be used.

The output stage is a Darlington emitter-follower (Q₈, Q₉) with an active current sink (Q₇). Transistor Q₁₀ provides short-circuit protection by limiting the output to 12 mA.

The biasing reference is a zener diode (Z₂) driven from a constant current source (Q₁₁). Supply decoupling is the ratio of the current source impedance to the zener impedance. To achieve the high current source impedance necessary for 120 dB supply rejection, a cascode configuration is used (Q₁₁ and Q₁₂). The reference voltage is used to power the first stages of the amplifier through emitter-followers Q₁₄ and Q₁₅. Resistor R₁ and zener Z₁ provide the starting mechanism for the regulator. After starting, zero volts appears across D₁ taking it out of conduction.

BIASING

Figure 3 shows an AC equivalent circuit of the LM381. The non-inverting input, Q₁, is referenced to a voltage source two V_{BE} above ground. The output quiescent point is established by negative DC feedback through the external divider R₄/R₅ (Figure 4).

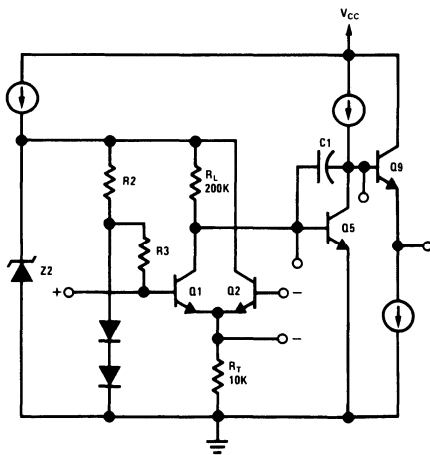


FIGURE 3. AC Equivalent Circuit

TL/H/7376-3

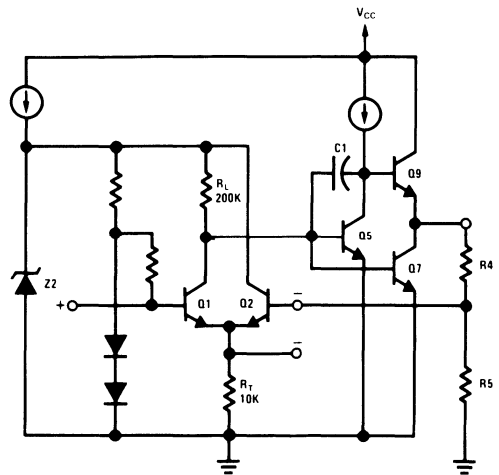


FIGURE 4. Differential Input Biasing

TL/H/7376-4

For bias stability, the current through R₅ is made ten times the input current of Q₂ (≈ 0.5 μA). Then, for the differential input, resistors R₅ and R₄ are:

$$R_5 = \frac{2 V_{BE}}{10 I_{Q2}} = \frac{1.2}{5 \times 10^6} = 240 \text{ k}\Omega \text{ MAXIMUM} \quad (3)$$

$$R_4 = \left(\frac{V_{CC}}{2.4} - 1 \right) R_5. \quad (4)$$

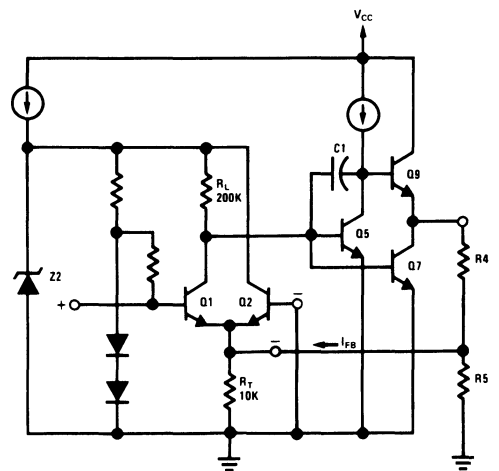


FIGURE 5. Single Ended Input Biasing

TL/H/7376-5

When using the single ended input, Q₂ is turned OFF and DC feedback is brought to the emitter of Q₁ (Figure 5). The impedance of the feedback summing point is now two orders of magnitude lower than the base of Q₂ (≈ 10 kΩ). Therefore, to preserve bias stability, the impedance of the

feedback network must be decreased. In keeping with reasonable resistance values, the impedance of the feedback voltage source can be $\frac{1}{5}$ the summing point impedance. The feedback current is $< 100 \mu\text{A}$ worst case. Therefore, for single ended input, resistors R_5 and R_4 are:

$$R_5 = \frac{V_{BE}}{5 I_{FB}} = \frac{0.6}{5 \times 10^{-4}} = 1200 \Omega \text{ MAXIMUM} \quad (5)$$

$$R_4 = \left(\frac{V_{CC}}{1.2} - 1 \right) R_5. \quad (6)$$

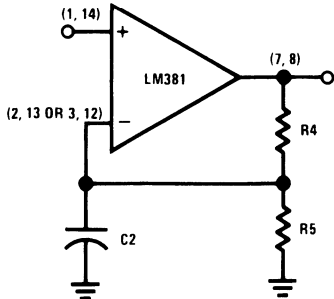


FIGURE 6. AC Open Loop

TL/H/7376-6

The circuits of Figures 4 and 5 have an AC and DC gain equal to the ratio R_4/R_5 . To open the AC gain, capacitor C_2 is used to shunt R_5 (Figure 6). The AC gain now approaches open loop. The low frequency 3 dB corner, f_0 , is given by:

$$f_0 = \frac{A_0}{2\pi C_2 R_4} \quad \text{where: } A_0 = \text{open loop gain} \quad (7)$$

TAPE PLAYBACK PREAMPLIFIER

Figure 7 shows the LM381 in a flat response tape playback configuration. The mid-band gain is set by resistor ratio

$$\frac{(R_4 + R_6)}{R_6} \quad (8)$$

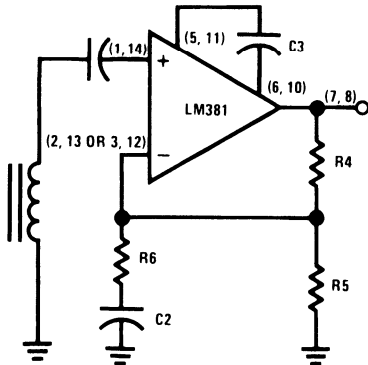


FIGURE 7. Flat Response Tape Amplifier

TL/H/7376-7

Capacitor C_2 sets the low frequency 3 dB corner where $X_{C_2} = R_6$

$$C_2 = \frac{1}{2\pi f_0 R_6} \quad (9)$$

The small-signal bandwidth of the LM381 is 15 MHz making the preamp suitable for wide-band instrumentation applications. However, in narrow-band applications it is desirable to limit the amplifier bandwidth and thus eliminate high frequency noise. Capacitor C_3 accomplishes this by shunting the internal pole-splitting capacitor (C_1), limiting the bandwidth of the amplifier. Thus, the high frequency 3 dB corner is set by C_3 according to equation 10.

$$C_3 = \frac{1}{2\pi f_3 r_e 10^{\frac{A}{20}}} - 4 \times 10^{-12} \quad (10)$$

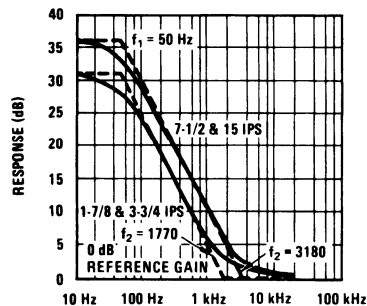
f_3 = high frequency 3 dB corner

r_e = first stage small-signal emitter resistance

$$\approx 2.6 \text{ k}\Omega$$

A = mid-band gain in dB

For music applications, response shaping is required to provide the NAB standard tape playback equalization. Figure 8 shows the NAB equalization characteristic.



TL/H/7376-8

FIGURE 8. NAB Equalization Characteristic

The NAB response is achieved with the circuit of Figure 9. Resistors R_4 and R_5 set the DC bias and are chosen according to equations 3 and 4 for differential input operation

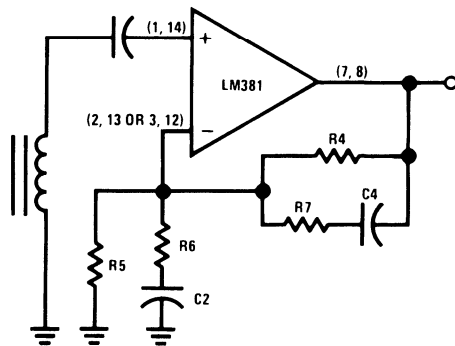


FIGURE 9. NAB Tape Preamp.

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and equations 5 and 6 for the single ended input. The reference gain of the preamp, above corner frequency f_2 (Figure 8), is set by the ratio:

$$0 \text{ dB reference gain} = \frac{R_7 + R_6}{R_6} \quad (11)$$

The corner frequency f_2 (Figure 8) is determined where $X_{C4} = R_7$ and is given by:

$$f_2 = \frac{1}{2\pi C_4 R_7} \quad (12)$$

Corner frequency f_1 is determined where $X_{C4} = R_4$:

$$f_1 = \frac{1}{2\pi C_4 R_4} \quad (13)$$

The low frequency 3 dB roll-off point, f_0 , is set where $X_{C2} = R_6$:

$$f_0 = \frac{1}{2\pi C_2 R_6} \quad (14)$$

Example: Design a NAB equalized preamp for a tape player requiring 0.5 Vrms output from a head sensitivity of 800 μ V at 1 kHz, 3 $\frac{3}{4}$ IPS. The power supply voltage is 24V and the differential input configuration is used.

1. From equation (3) let $R_5 = 240$ k Ω .

2. Equation (4) $R_4 = \left(\frac{V_{CC}}{2.4} - 1\right) R_5$

$$R_4 = \left(\frac{24}{2.4} - 1\right) 2.4 \times 10^5$$

$$R_4 = 2.16 \times 10^5 \approx 2.2$$
 M Ω

3. For a corner frequency, f_1 equal to 50 Hz, equation (13) is used.

$$C_4 = \frac{1}{2\pi f_1 R_4} = \frac{1}{6.28 \times 50 \times 2.2 \times 10^6} \quad (13)$$

$$= 1.44 \times 10^{-9}$$

$$C_4 \approx 1500$$
 pF.

4. From Figure 8, the corner frequency $f_2 = 1770$ Hz at 3 $\frac{3}{4}$ IPS. Resistor R_7 is found from equation (12).

$$C_4 = \frac{1}{2\pi f_2 R_7}$$

$$R_7 = \frac{1}{6.28 \times 1770 \times 1.5 \times 10^{-9}} = 6 \times 10^4 \quad (12)$$

$$R_7 \approx 62$$
 k Ω .

5. The required voltage gain at 1 kHz is:

$$A_V = \frac{0.5 \text{ Vrms}}{800 \mu\text{Vrms}} = 6.25 \times 10^2 \text{ V/V} = 56 \text{ dB.}$$

6. From Figure 8 we see the reference frequency gain, above f_2 , is 5 dB down from the 1 kHz value or 51 dB (355 V/V).

Equation (11)

$$0 \text{ dB Reference Gain} = \frac{R_7 + R_6}{R_6} = 355$$

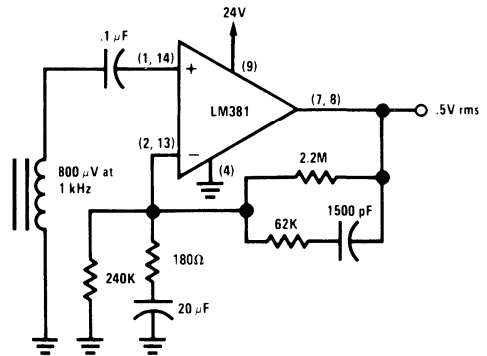
$$R_6 = \frac{R_7}{355 - 1} = \frac{62\text{k}}{354} = 175$$

$$R_6 \approx 180\Omega.$$

7. For low frequency corner $f_0 = 40$ Hz, equation (14)

$$C_2 = \frac{1}{2\pi f_0 R_6} = \frac{1}{6.28 \times 40 \times 180} = 2.21 \times 10^{-5}$$

$$C_2 \approx 20 \mu\text{F.}$$



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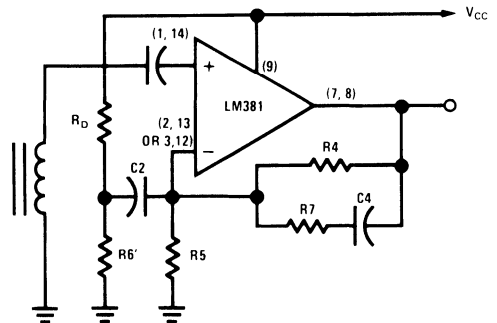
FIGURE 10. Typical Tape Playback Amplifier

This circuit is shown in Figure 10 and requires approximately 5 seconds to turn-ON for the gain and supply voltage chosen in the example. Turn-ON time can closely be approximated by:

$$t_{ON} \approx -R_4 C_2 \ln \left(1 - \frac{2.4}{V_{CC}}\right). \quad (15)$$

As seen by equation (15), increasing the supply voltage decreases turn-ON time. Decreasing the amplifier gain also decreases turn-ON time by reducing the $R_4 C_2$ product.

Where the turn-ON time of the circuit of Figure 9 is too long, the time may be shortened by using the circuit of Figure 11. The addition of resistor R_D forms a voltage divider with R_6' . This divider is chosen so that zero DC voltage appears



TL/H/7376-11

FIGURE 11. Fast Turn-ON NAB Tape Preamp

across C_2 . The parallel resistance of R_6' and R_D is made equal to the value of R_6 found by equation (11). In most cases the shunting effect of R_D is negligible and $R_6' \approx R_6$. For differential input, R_D is given by:

$$R_D = \frac{(V_{CC} - 1.2) R_6'}{1.2} \quad (16)$$

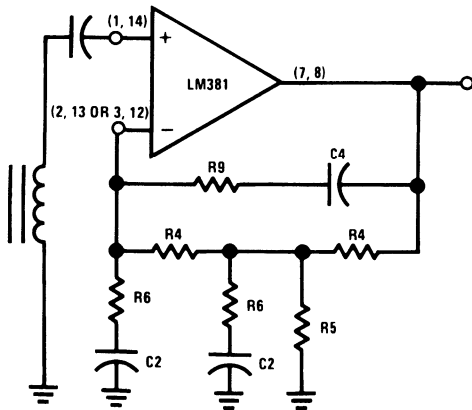
For single ended input:

$$R_D = \frac{(V_{CC} - 0.6) R_6'}{0.6} \quad (17)$$

In cases where power supply ripple is excessive, the circuit of Figure 11 cannot be used since the ripple is coupled into the input of the preamplifier through the divider.

The circuit of Figure 12 provides fast turn-ON while preserving the 120 dB power supply rejection.

The DC operating point is still established by R_4/R_5 . However, equations (3) and (5) are modified by a factor of 10 to preserve DC bias stability.



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FIGURE 12. Two-Pole Fast Turn-On NAB Tape Preamp.

For differential input, equation (3) is modified as:

$$(3A) \quad R_5 = \frac{2 V_{BE}}{100 I_{Q2}} = \frac{1.2}{50 \times 10^{-8}} \\ = 24 \text{ k}\Omega \text{ MAXIMUM.}$$

For single ended input:

$$\text{Equation (5A)} \quad R_5 = \frac{V_{BE}}{50 I_{FB}} = \frac{0.6}{50 \times 10^{-4}} \\ = 120 \Omega \text{ MAXIMUM.}$$

Equations (11), (12) and (14) describe the high frequency gain and corner frequencies f_2 and f_0 as before. Frequency f_1 now occurs where X_{C4} equals the composite impedance of the R_4, R_6, C_2 network as given by equation (18).

$$C_4 = \frac{1}{2\pi f_1 R_6 \left[\left(\frac{R_4 + R_6}{R_6} \right)^2 - 1 \right]} \quad (18)$$

The turn-ON time becomes:

$$t_{ON} \approx -2\sqrt{R_4 C_2} \ln \left(1 - \frac{2.4}{V_{CC}} \right). \quad (19)$$

Examples: Design an NAB equalized preamp with the fast turn-ON circuit of Figure 12 for the same requirements as the previous example.

1. From equation (3A) let $R_5 = 24 \text{ k}\Omega$.

$$2. \text{ Equation (4)} \quad R_4 = \left(\frac{V_{CC}}{2.4} - 1 \right) R_5 \\ = \left(\frac{24}{2.4} - 1 \right) 24 \times 10^3 \\ R_4 = 2.16 \times 10^5 \approx 220 \text{ k}\Omega.$$

3. From the previous example the reference frequency gain, above f_2 , was found to be 51 dB or 355 V/V.

$$\text{Equation (11)} \quad \frac{R_7 + R_6}{R_6} = 355.$$

4. The corner frequency f_2 is 1770 Hz for 3-3/4 IPS.

$$\text{Equation (12)} \quad C_4 = \frac{1}{2\pi f_2 R_7}$$

5. The corner frequency f_1 is 50 Hz and is given by equation (18).

$$(18) \quad C_4 = \frac{1}{2\pi f_1 R_6 \left[\left(\frac{R_4 + R_6}{R_6} \right)^2 - 1 \right]}$$

6. Solving equations (11), (12), and (18) simultaneously gives:

$$R_6 = \frac{R_4 (f_1 + \sqrt{f_1^2 + f_1 f_2 (\text{Ref. Gain})})}{f_2 (\text{Ref. Gain})} \quad (20)$$

$$R_6 = \frac{2.2 \times 10^5 (50 + \sqrt{2500 + 50 \times 1770 \times 355})}{1770 \times 355} \\ = 1.98 \times 10^3$$

$$R_6 \approx 2 \text{ k}\Omega.$$

7. From equation (11) $R_7 = 354 R_6 = 708 \times 10^3$, $R_7 \approx 680 \text{ k}\Omega$.

$$8. \text{ Equation (12)} \quad C_4 = \frac{1}{2\pi f_2 R_7} \\ = \frac{1}{6.28 \times 1770 \times 680 \times 10^3} \\ C_4 = 1.32 \times 10^{-10} \approx 120 \text{ pF.}$$

$$9. \text{ Equation (14)} \quad C_2 = \frac{1}{2\pi f_0 R_6} \\ = \frac{1}{6.28 \times 40 \times 2 \times 10^3} \\ C_2 = 1.99 \times 10^{-6} \approx 2 \mu\text{F.}$$

This circuit is shown in *Figure 13* and requires only 0.1 seconds to turn-ON.

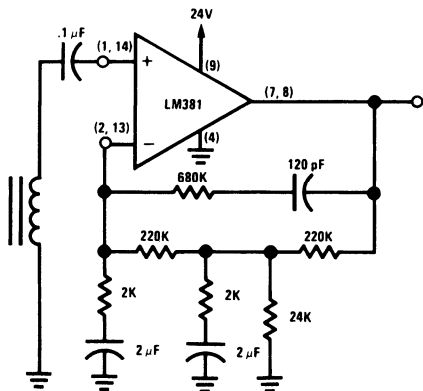
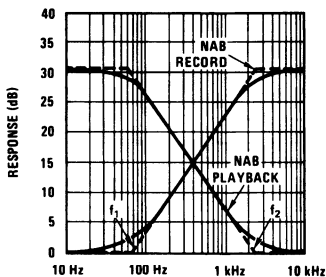


FIGURE 13

TL/H/7376-13

TAPE RECORD PREAMPLIFIER

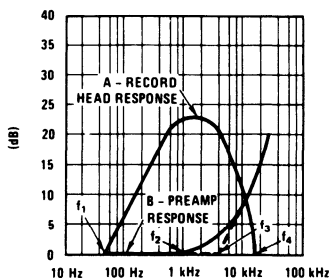
When recording, the frequency response is the complement of the NAB playback equalization, making the composite record and playback response flat. *Figure 14* shows the record characteristic superimposed on the NAB playback response.



TL/H/7376-14

FIGURE 14. NAB Record & Playback Equalization

Curve A of *Figure 15* shows the response characteristics of a typical laminated core, quartertrack head.



TL/H/7376-15

FIGURE 15. Recording Head & Preamp. Response for NAB Equalization

Curve B shows the required preamplifier response to make the composite, A + B, provide the NAB recording characteristic. This response is obtained with the circuit of *Figure 16*. Resistors R_4 and R_5 set the DC bias as before using equations (3) and (4) for the differential input and equations (5) and (6) for the single ended input. Resistor R_6 and capacitor C_2 set the mid-band gain as before (equations (8) and (9)). Capacitor C_5 sets the high frequency 3 dB point, f_3 , (*Figure 15*) as:

$$f_3 = \frac{1}{2\pi C_5 R_6} \quad (21)$$

The preamp gain increases at 6 dB/octave above f_3 until $R_8 = X_{C_5}$.

$$R_8 = \frac{1}{2\pi f_4 C_5} \quad (22)$$

f_4 = desired high frequency cutoff

Resistor R_9 is chosen to provide the proper recording head current.

$$R_9 = \frac{V_o}{I_{RECORD HEAD}} \quad (23)$$

L_1 and C_6 form a parallel resonant bias trap to present a high impedance to the recording bias frequency and prevent intermodulation distortion.

Example: A recorder having a 24V power supply uses recording heads requiring 30 μA AC drive current. A microphone of 10 mV peak output is used. Single ended input is desired for optimum noise performance.

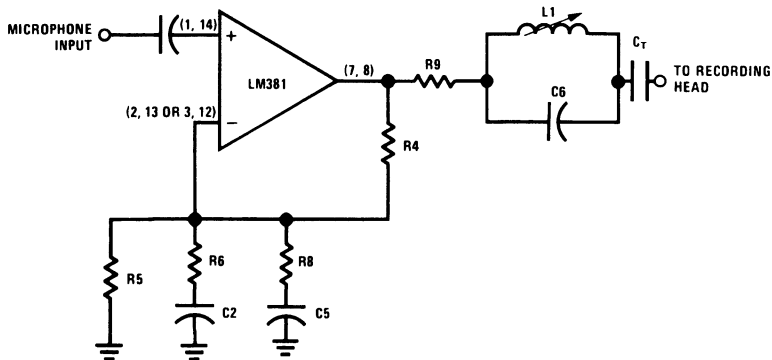


FIGURE 16. Tape Recording Preamp.

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- From equation (5) let $R_5 = 1200\Omega$.
- Equation (6) $R_4 = \left(\frac{V_{CC}}{1.2} - 1\right) R_5$

$$R_4 = \left(\frac{24}{1.2} - 1\right) 1200.$$

$$R_4 = 2.28 \times 10^4 \approx 22 \text{ k}\Omega.$$
- The maximum output of the LM381 is $(V_{CC} - 2V)_{p-p}$. For a 24V power supply, the maximum output is $22V_{p-p}$ or 7.8 Vrms. Therefore, an output swing of 6 Vrms is reasonable.

From equation (23) $R_9 = \frac{V_O}{I_{\text{RECORD HEAD}}}$

$$R_9 = \frac{6V}{30 \mu A} = 200 \text{ k}\Omega.$$

- Let the high frequency cutoff $f_4 = 16 \text{ kHz}$ (Figure 15). The recording head frequency response begins falling off at approximately 4 kHz. Therefore, the preamp gain must increase at this frequency to obtain the proper composite characteristic. The slope is 6 dB/octave for the two octaves between f_3 (4 kHz) and the cutoff frequency f_4 (16 kHz). Therefore, the mid-band gain lies 12 dB below the peak gain.

We are allowing 6V rms output voltage swing.

Therefore, the peak gain = $\frac{6V}{10 \text{ mV}} = 600$ or 55.6 dB.

The mid-band gain = 43.6 dB or 150.

- From equation (8) the mid-band gain =

$$\frac{R_4 + R_6}{R_6} = 150.$$

$$R_6 = \frac{R_4}{149} = \frac{22 \times 10^3}{149} = 147.7$$

$$R_6 \approx 150\Omega.$$

$$6. \text{ Equation (9) } C_2 = \frac{1}{2\pi f_0 R_6}$$

$$= \frac{1}{6.28 \times 50 \times 150}$$

$$= 2.12 \times 10^{-5}$$

$$C_2 \approx 20 \mu F.$$

$$7. \text{ Equation (21) } C_5 = \frac{1}{2\pi f_3 R_6}$$

$$= \frac{1}{6.28 \times 4 \times 10^3 \times 150}$$

$$= 2.66 \times 10^{-7}$$

$$C_5 \approx 0.27 \mu F.$$

$$8. \text{ Equation (22) } R_8 = \frac{1}{2\pi f_4 C_5}$$

$$= \frac{1}{6.28 \times 16 \times 10^3 \times 2.7 \times 10^{-7}}$$

$$= 36.8$$

$$R_8 \approx 33\Omega.$$

PHONO PREAMPLIFIER

Crystal and ceramic phono cartridges provide output levels of 100 mV to 2V and therefore do not require preamplification. Magnetic cartridges, however, provide much lower outputs as shown in Table 2.

TABLE 2

Manufacturer	Model	Output At 5 cm/sec
Empire Scientific	999	5 mV
	888	8 mV
Shure	V-15	3.5 mV
	M91	5 mV
Pickering	V-15 AT3	5 mV

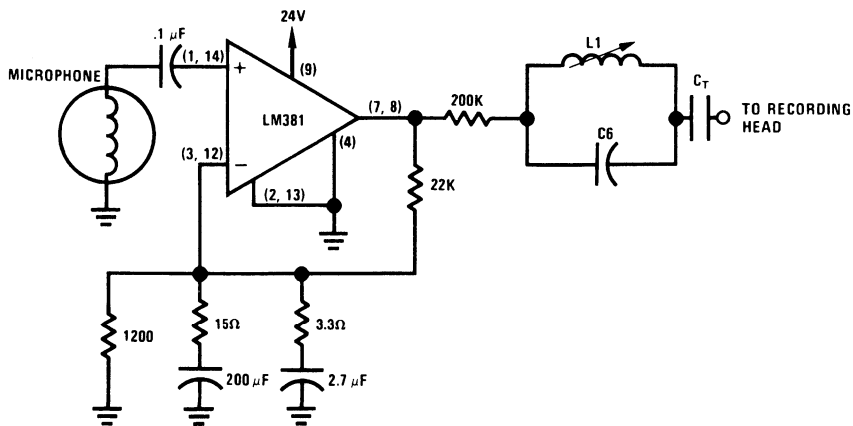


FIGURE 17. Typical Tape Recording Amplifier

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Output voltage is specified for a given modulation velocity. The magnetic pickup is a velocity device, therefore, output is proportional to velocity. For example, a cartridge producing 5 mV at 5 cm/sec will produce 1 mV at 1 cm/sec and is specified as having a sensitivity of 1 mV/cm/sec.

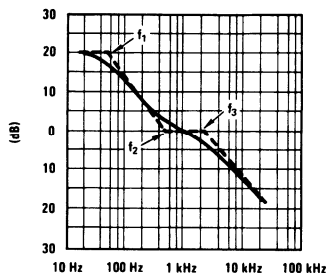
In order to transform cartridge sensitivity into useful preamp design information, we need to know typical and maximum modulation velocity limits of stereo records.

The RIAA recording characteristic establishes a maximum recording velocity of 25 centimeters per second in the range of 800 to 2500 Hz. Typically, good quality records are recorded at a velocity of 3 to 5 cm/sec.

Figure 18 shows the RIAA playback equalization. This response is obtained with the circuit of Figure 19.

Resistors R_4 and R_5 set the DC bias (equations (3) and (4), or (5) and (6)). The 0 dB reference gain is set by the ratio:

$$0 \text{ dB Ref Gain} = \frac{R_{10} + R_6}{R_6} \quad (24)$$

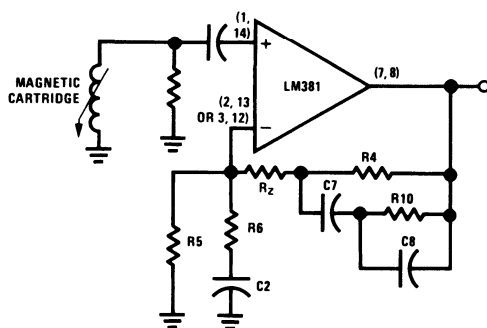


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FIGURE 18. RIAA Playback Equalization

The corner frequency, f_1 , (Figure 18) is established where $X_{C7} = R_4$ or:

$$C_7 = \frac{1}{2\pi f_1 R_4} \quad (25)$$



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FIGURE 19. RIAA Phono Preamp.

Likewise, frequency f_2 occurs where $X_{C7} = R_{10}$ or:

$$C_7 = \frac{1}{2\pi f_2 R_{10}} \quad (26)$$

The third corner frequency, f_3 , is determined where $X_{C8} = R_{10}$:

$$C_8 = \frac{1}{2\pi f_3 R_{10}} \quad (27)$$

Resistor R_z is used to insert a zero in the feedback loop since the LM381 is not compensated for unity gain. Either R_z is required to provide a zero at or above a gain of 20 dB ($R_z = 10 R_6$), or external compensation is provided for unity gain stability according to equation (10).

Example: Design a phonograph preamp operating from a 30 volt supply, with a cartridge of 0.5 mV/cm/sec sensitivity, to drive a power amplifier of 5 Vrms input overload limit.

1. From equation (3) let $R_5 = 100 \text{ k}\Omega$.

$$\begin{aligned} \text{2. Equation (4)} \quad R_4 &= \left(\frac{V_{CC}}{2.4} - 1 \right) R_5 \\ &= \left(\frac{30}{2.4} - 1 \right) 10^5 \\ R_4 &= 11.5 \times 10^5 \approx 1.2 \text{ M}\Omega. \end{aligned}$$

$$\begin{aligned} \text{3. Equation (25)} \quad C_7 &= \frac{1}{2\pi f_1 R_4} \\ &= \frac{1}{6.28 \times 50 \times 1.2 \times 10^6} \\ &= 2.65 \times 10^{-9} \end{aligned}$$

$$C_7 \approx .003 \mu\text{F}.$$

$$\text{4. Equation (26)} \quad C_7 = \frac{1}{2\pi f_2 R_{10}};$$

$$\begin{aligned} R_{10} &= \frac{1}{6.28 \times 500 \times 3 \times 10^{-9}} \\ &= 1.03 \times 10^5 \end{aligned}$$

$$R_{10} \approx 100 \text{ k}\Omega.$$

5. The maximum cartridge output at 25cm/sec is:
(0.5 mV/cm/sec) \times (25 cm/sec) = 12.5 mV. The required mid-band gain is therefore:

$$\frac{5 \text{ V rms}}{12.5 \text{ mV rms}} = 400.$$

6. Equation (24)

$$0 \text{ dB Ref. Gain} = \frac{R_{10} + R_6}{R_6} = 400;$$

$$R_6 = \frac{100\text{k}}{399} = 251 \approx 240\Omega$$

$$R_z = 10 R_6 = 2400\Omega.$$

7. Equation (9)

$$C_2 = \frac{1}{2\pi f_0 R_6} = \frac{1}{6.28 \times 40 \times 240} = 1.7 \times 10^{-5}$$

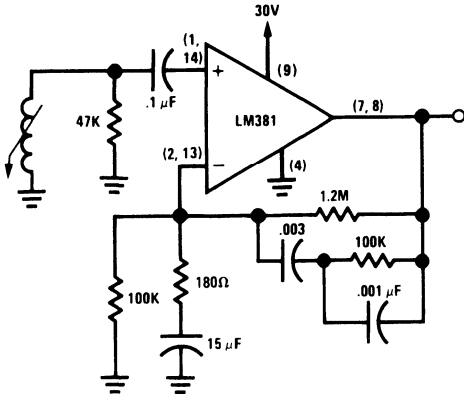
$$C_2 \approx 20 \mu\text{F}.$$

8. Equation (27)

$$\begin{aligned} C_8 &= \frac{1}{2\pi f_3 R_{10}} \\ &= \frac{1}{6.28 \times 2200 \times 6.8 \times 10^4} \\ &= 7.23 \times 10^{-10} \end{aligned}$$

$$C_8 \approx 0.001 \mu\text{F}.$$

The completed design is shown in *Figure 20* where a 47 kΩ input resistor has been included to provide the RIAA standard cartridge load.

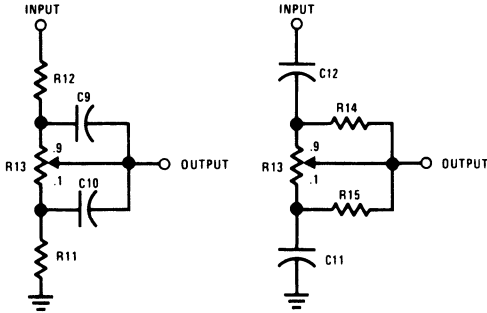


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FIGURE 20. Typical Magnetic Phono Preamp.

tone controls

Most tape and phonograph applications require bass and treble tone controls. Due to the insertion loss of the tone control, (equal to the available boost), it has been normal to use two preamplifiers with the control placed between them. However, due to the excellent gain and large output capability of the LM381, only a single preamp is required.



TL/H/7376-21

FIGURE 21. Bass & Treble Controls

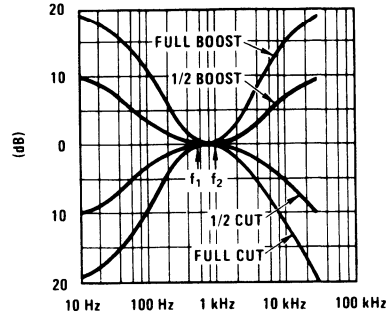
Figure 21 shows the bass and treble tone controls. The potentiometers, R₁₃, are audio taper; i.e., at the center of shaft rotation the wiper is at the 90%–10% point of the total resistance. Both controls are simple AC dividers, with the flat response position where the signal is attenuated from the “full boost”.

In the bass control the ratio of resistors R₁₁/R₁₂ and R₁₂/R₁₃ determine the degree of “boost” and “cut”. For

example, if 20 dB of “boost” and “cut” is desired, the ratio R₁₁/R₁₂ and R₁₂/R₁₃ is 20 dB or 10:1. The low frequency control point, f₁, (*Figure 22*) is set where X_{C9} = R₁₂ and X_{C10} = R₁₁.

$$C_9 = \frac{1}{2\pi f_1 R_{12}} \tag{28}$$

$$C_{10} = \frac{1}{2\pi f_1 R_{11}} \tag{29}$$



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FIGURE 22. Bass & Treble Tone Control Response for 20 dB Boost & Attenuation

The treble control is the analogue of the bass control with the resistor and capacitor dividers reversed. The ratio of reactance of C₁₁/C₁₂ is set equal to the amount of “boost” and “cut”. The high frequency control point, f₂, is established where X_{C12} = R₁₃.

$$C_{12} = \frac{1}{2\pi f_2 R_{13}} \tag{30}$$

$$R_{14} = \frac{1}{2\pi f_2 C_{12}} \tag{31}$$

$$R_{15} = \frac{1}{2\pi f_2 C_{11}} \tag{32}$$

Figure 23 shows one channel of a practical preamplifier for a stereo phonograph. The preamp is complete with RIAA equalization, bass and treble tone control, balance control and volume control.

audio mixer

In many audio applications it is desirable to provide a mixer to combine or select several inputs. Such applications include public address systems where more than one microphone is used; tape recorders, high fidelity phonographs, guitar amplifiers, etc.

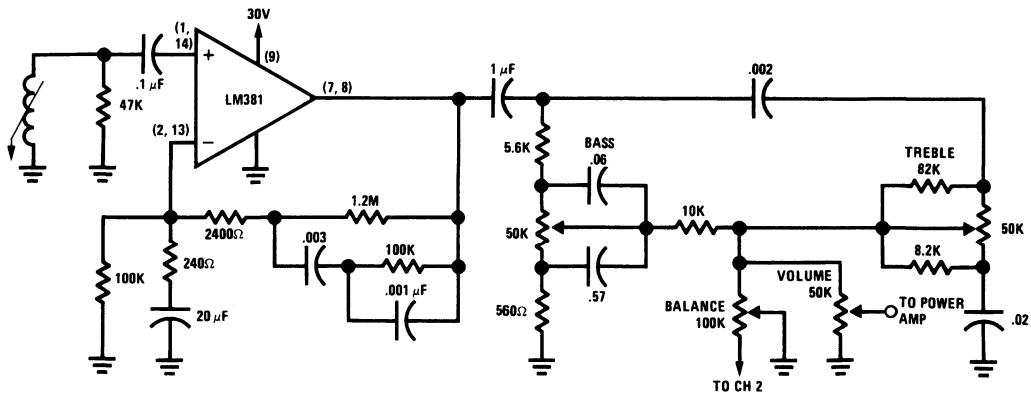


FIGURE 23. Single Channel of Complete Phono Preamp.

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Figure 24 shows the LM381 in a mixer configuration. Inputs at A, B, C, -N can be selected and combined (summed) with potentiometers R_A , R_B , R_C , - R_N . Resistors R_4 and R_5 establish the DC quiescent point in accordance with equations (3A) and (4). (Only the differential input configuration is used in the mixer application since the high source impedance of the input potentiometers would negate any advantage of the single ended input.) Input bias current is supplied through resistor R_F . Therefore, an upper limit of R_F should be established to avoid output offset voltage problems. A safe upper limit is to let:

$$R_F = R_4 \text{ MAXIMUM} \quad (33)$$

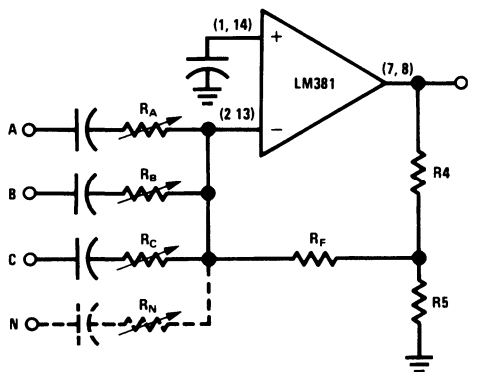


FIGURE 24. Audio Mixer

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The voltage gain of the mixer is:

$$|A_{V_{A,B,C}}| = \frac{R_4 R_F + R_4 R_5 + R_5 R_F}{R_5 (R_{A,B,C} + R_{S_{A,B,C}})} \quad (34)$$

Where the values of R_F and the source impedance, R_S , are such that the gain of the circuit of Figure 24 is inadequate, the configuration of Figure 25 may be used.

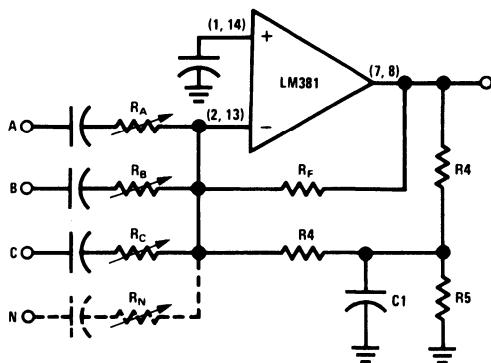


FIGURE 25

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The voltage gain of the mixer is now:

$$|A_V| = \frac{R_F}{R_{A,B,C} + R_{S_{A,B,C}}} \quad (35)$$

Since resistor R_F is no longer required to supply the input bias current, it does not have the upper limit as in the previous circuit. Therefore, the open loop gain of the LM381 can be realized. Capacitor C_1 , shunts the AC feedback of the R_4 - R_5 network and is found by:

$$C_1 = \frac{A_o}{2\pi f_o R_4}$$

A_o = amplifier open loop gain in dB

f_o = low frequency 3 dB corner

Example: Design a microphone mixer for use with 600Ω dynamic microphones with an output level of 10 mV. The mixer should operate from a 24V supply and deliver 5 volts output. A dynamic range of 80 dB is desired.

1. From equation (3A) $R_5 = 24 \text{ k}\Omega$

2. Equation (4)

$$R_4 = \left(\frac{V_{CC}}{2.4} - 1 \right) R_5$$

$$R_4 = \left(\frac{24}{2.4} - 1 \right) 24 \times 10^3$$

$$R_4 = 2.16 \times 10^5 \approx 220 \text{ k}\Omega$$

3. For 5V output:

$$\text{Gain} = \frac{5V}{10 \text{ mV}} = 500$$

4. For 80 dB dynamic range:

$$\text{Attenuation} = \frac{500}{80 \text{ dB}} = 5 \times 10^{-2}$$

5. Equation (34)

$$|A_V| = \frac{R_4 R_F + R_4 R_5 + R_5 R_F}{R_5 (R_{A,B,C} + R_5)}$$

$$R_F = \frac{|A_V| R_5 (R_{A,B,C} + R_5) - R_4 R_5}{R_4 + R_5}$$

At maximum volume: $R_{A,B,C} = 0$, Gain = 500

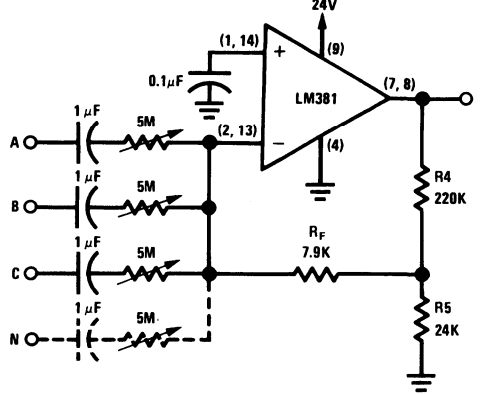
$$R_F = \frac{500 \times 24 \times 10^4 (0 + 600) - (2.2 \times 10^5) (24 \times 10^4)}{2.2 \times 10^5 + 24 \times 10^4}$$

$$R_F = 7.87\text{k} \approx 8.2\text{k}$$

At maximum attenuation:

$$R_{A,B,C} = \frac{R_4 R_F + R_4 R_5 + R_5 R_F - |A_V| R_5 R_5}{A_V R_5}$$

$$R_{A,B,C} = 5.99 \times 10^6 \approx 5\text{M}\Omega$$



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FIGURE 26

CONCLUSION

The applications presented in this note are by no means exhaustive. The LM381 is a widely versatile low noise, high gain, wide band gain block and, as such has many applications outside the audio spectrum.

LM380 Power Audio Amplifier

National Semiconductor
Application Note 69



AN-69

INTRODUCTION

The LM380 is a power audio amplifier intended for consumer applications. It features an internally fixed gain of 50 (34 dB) and an output which automatically centers itself at one-half of the supply voltage. A unique input stage allows inputs to be ground referenced or AC coupled as required. The output stage of the LM380 is protected with both short circuit current limiting and thermal shutdown circuitry. All of these internally provided features result in a minimum external parts count integrated circuit for audio applications.

This paper describes the circuit operation of the LM380, its power handling capability, methods of volume and tone control, distortion, and various application circuits such as a bridge amplifier, a power supply splitter, and a high input impedance audio amplifier.

CIRCUIT DESCRIPTION

Figure 1 shows a simplified circuit schematic of the LM380. The input stage is a PNP emitter-follower driving a PNP differential pair with a slave current-source load. The PNP

input is chosen to reference the input to ground, thus enabling the input transducer to be directly coupled.

The output is biased to half the supply voltage by resistor ratio R_1/R_2 . Negative DC feedback, through resistor R_2 , balances the differential stage with the output at half supply, since $R_1 = 2 R_2$ (Figure 1).

The second stage is a common emitter voltage gain amplifier with a current-source load. Internal compensation is provided by the pole-splitting capacitor C' . Pole-splitting compensation is used to preserve wide power bandwidth (100 kHz at 2W, 8Ω). The output is a quasi-complementary pair emitter-follower.

The amplifier gain is internally fixed to 34 dB or 50. This is accomplished by the internal feedback network R_2-R_3 . The gain is twice that of the ratio R_2/R_3 due to the slave current-source which provides the full differential gain of the input stage.

TABLE I. Electrical Characteristics (Note 1)

Parameter	Conditions	Min	Typ	Max	Units
Power Output (rms)	8Ω loads, 3% T.H.D. (Notes 3,4)	2.5			Wrms
Gain		40	50	60	V/V
Output Voltage Swing	8Ω load		14		V_{p-p}
Input Resistance			150k		Ω
Total Harmonic Distortion	$P_o = 1W$, (Notes 4 & 5)		0.2		%
Power Supply Rejection	$C_{bypass} = 5 \mu F$, $f = 120$ Hz (Note 2)		38		dB
Supply Voltage Range		8		22	V
Bandwidth	$P_o = 2W$, $R_L = 8\Omega$		100k		Hz
Quiescent Output Voltage		8	9	10	V
Quiescent Supply Current			7	25	mA
Short Circuit Current			1.3		A

Note 1: $V_S = 18V$; $T_A = 25^\circ C$ unless otherwise specified.

Note 2: Rejection ratio referred to output.

Note 3: With device Pins 3, 4, 5, 10, 11, 12 soldered into a $1/16"$ epoxy glass board with 2 ounce copper foil with a minimum surface of six square inches.

Note 4: If oscillation exists under some load conditions, add a 2.7Ω resistor and $0.1 \mu F$ series network from Pin 8 to ground.

Note 5: $C_{bypass} = 0.47 \mu F$ on Pin 1.

Note 6: Pins 3, 4, 5, 10, 11, 12 at $50^\circ C$ derates $25^\circ C/W$ above $50^\circ C$ case.

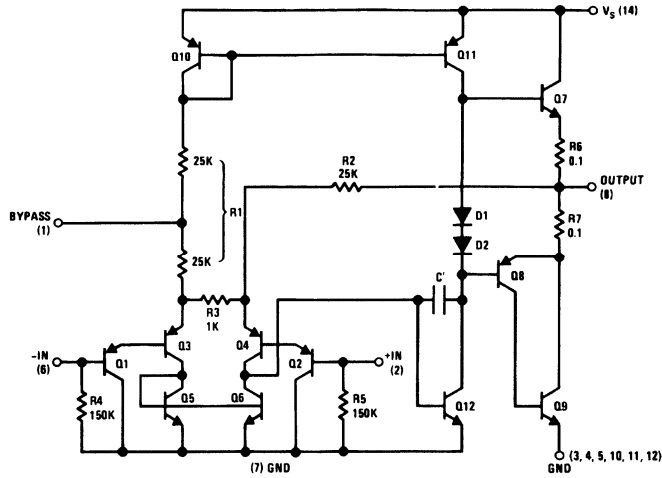


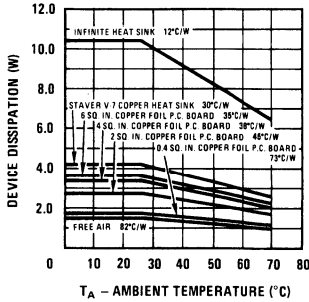
FIGURE 1

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GENERAL OPERATING CHARACTERISTICS

The output current of the LM380 is rated at 1.3A peak. The 14 pin dual-in-line package is rated at 35°C/W when soldered into a printed circuit board with 6 square inches of 2 ounce copper foil (Figure 2). Since the device junction temperature is limited to 150°C via the thermal shutdown circuitry, the package will support 3 watts dissipation at 50°C ambient or 3.7 watts at 25°C ambient.

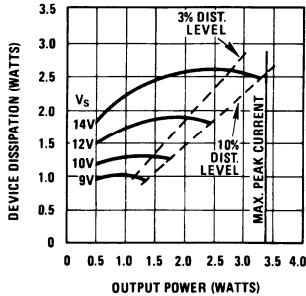
Figure 2 shows the maximum package dissipation versus ambient temperature for various amounts of heat sinking.



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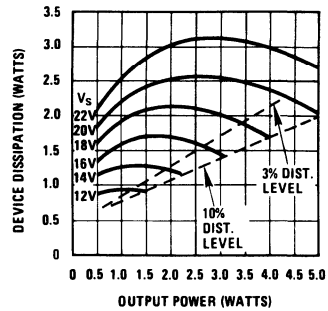
FIGURE 2. Device Dissipation vs Ambient Temperature

Figures 3a, b, and c show device dissipation versus output power for various supply voltages and loads.



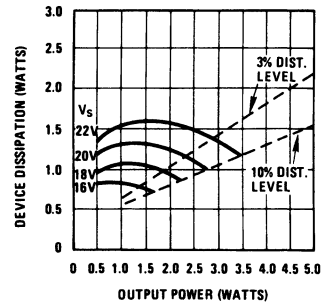
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FIGURE 3a. Device Dissipation vs Output Power — 4Ω Load



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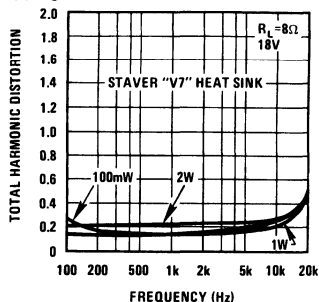
FIGURE 3b. Device Dissipation vs Output Power — 8Ω Load



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FIGURE 3c. Device Dissipation vs Output Power — 16Ω Load

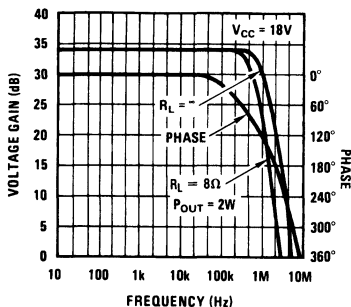
The maximum device dissipation is obtained from *Figure 2* for the heat sink and ambient temperature conditions under which the device will be operating. With this maximum allowed dissipation, *Figures 3a, b* and *c* show the maximum power supply allowed (to stay within dissipation limits) and the output power delivered into 4, 8 or 16 Ω loads. The three percent total-harmonic distortion line is approximately the on-set of clipping.



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FIGURE 4. Total Harmonic Distortion vs Frequency

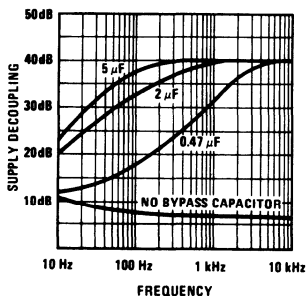
Figure 4 shows total harmonic distortion versus frequency for various output levels, while *Figure 5* shows the power bandwidth of the LM380.



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FIGURE 5. Output Voltage Gain vs Frequency

Power supply decoupling is achieved through the AC divider formed by R_1 (*Figure 1*) and an external bypass capacitor. Resistor R_1 is split into two 25 k Ω halves providing a high



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FIGURE 6. Supply Decoupling vs Frequency

source impedance for the integrator. *Figure 6* shows supply decoupling versus frequency for various bypass capacitors.

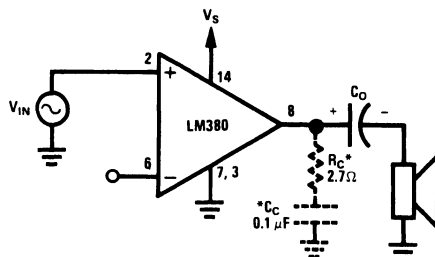
BIASING

The simplified schematic of *Figure 1* shows that the LM380 is internally biased with the 150 k Ω resistance to ground. This enables input transducers which are referenced to ground to be direct-coupled to either the inverting or non-inverting inputs of the amplifier. The unused input may be either: 1) left floating, 2) returned to ground through a resistor or capacitor or 3) shorted to ground. In most applications where the non-inverting input is used, the inverting input is left floating. When the inverting input is used and the non-inverting input is left floating, the amplifier may be found to be sensitive to board layout since stray coupling to the floating input is positive feedback. This can be avoided by employing one of three alternatives: 1) AC grounding the unused input with a small capacitor. This is preferred when using high source impedance transducer. 2) Returning the unused input to ground through a resistor. This is preferred when using moderate to low DC source impedance transducers and when output offset from half supply voltage is critical. The resistor is made equal to the resistance of the input transducer, thus maintaining balance in the input differential amplifier and minimizing output offset. 3) Shorting the unused input to ground. This is used with low DC source impedance transducers or when output offset voltage is non-critical.

OSCILLATION

The normal power supply decoupling precautions should be taken when installing the LM380. If V_S is more than 2" to 3" from the power supply filter capacitor it should be decoupled with a 0.1 μ F disc ceramic capacitor at the V_S terminal of the IC.

The R_C and C_C shown as dotted line components on *Figure 7* and throughout this paper suppresses a 5 to 10 MHz



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*For Stability With High Current Loads

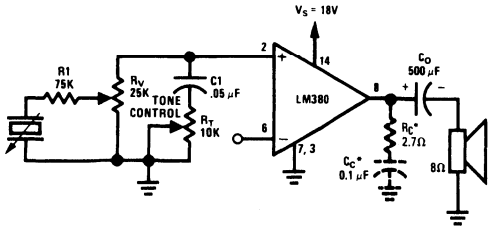
FIGURE 7. Minimum Component Configuration

small amplitude oscillation which can occur during the negative swing into a load which draws high current. The oscillation is of course at too high a frequency to pass through a speaker, but it should be guarded against when operating in an RF sensitive environment.

APPLICATIONS

With the internal biasing and compensation of the LM380, the simplest and most basic circuit configuration requires only an output coupling capacitor as seen in *Figure 7*.

An application of this basic configuration is the phonograph amplifier where the addition of volume and tone controls is required. *Figure 8* shows the LM380 with a voltage divider volume control and high frequency roll-off tone control.

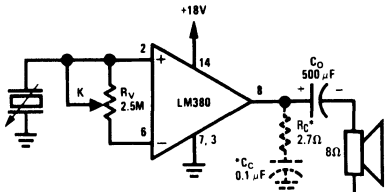


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*For Stability with High Current Loads

FIGURE 8. Phono Amp

When maximum input impedance is required or the signal attenuation of the voltage divider volume control is undesirable, a "common mode" volume control may be used as seen in *Figure 9*.



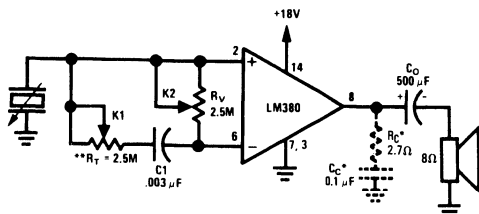
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*For Stability with High Current Loads

FIGURE 9. "Common Mode" Volume Control

With this volume control the source loading impedance is only the input impedance of the amplifier when in the full-volume position. This reduces to one-half the amplifier input impedance at the zero volume position. Equation 1 describes the output voltage as a function of the potentiometer setting.

$$V_{OUT} = 50 V_{IN} \left(1 - \frac{150 \times 10^3}{k_1 R_V + 150 \times 10^3} \right) \quad 0 \leq k_1 \leq 1 \quad (1)$$



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*For Stability with High Current Loads

**Audio Tape Potentiometer (10% of R_T at 50% Rotation)

FIGURE 10. "Common Mode" Volume and Tone Control

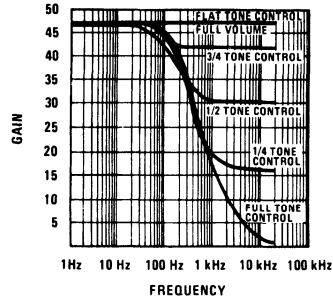
This "common mode" volume control can be combined with a "common mode" tone control as seen in *Figure 10*.

This circuit has a distinct advantage over the circuit of *Figure 7* when transducers of high source impedance are used, in that, the full input impedance of the amplifier is realized. It also has an advantage with transducers of low source impedance since the signal attenuation of the input voltage divider is eliminated. The transfer function of the circuit of *Figure 10* is given by:

$$\frac{V_{OUT}}{V_{IN}} = 50 \left(1 - \frac{150k}{k_1 R_T k_2 R_V + \frac{k_2 R_V}{j2\pi f c_1}} \right) \quad (2)$$

$$\frac{1}{k_1 R_T + k_2 R_V + \frac{1}{j2\pi f c_1}} \quad \begin{matrix} 0 \leq k_1 \leq 1 \\ 0 \leq k_2 \leq 1 \end{matrix}$$

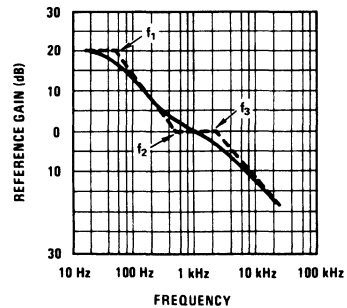
Figure 11 shows the response of the circuit of *Figure 10*.



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FIGURE 11. Tone Control Response

Most phonograph applications require frequency response shaping to provide the RIAA equalization characteristic. When recording, the low frequencies are attenuated to prevent large undulations from destroying the record groove walls. (Bass tones have higher energy content than high frequency tones). Conversely, the high frequencies are emphasized to achieve greater signal-to-noise ratio. Therefore, when played back the phono amplifier should have the inverse frequency response as shown in *Figure 12*.



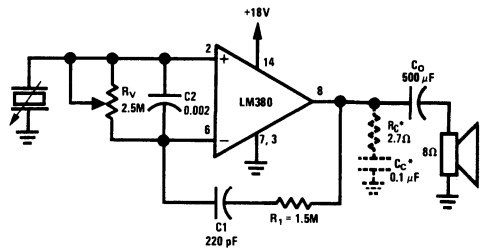
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FIGURE 12. RIAA Playback Equalization

This response is achieved with the circuit of *Figure 13*.

The mid-band gain, between frequencies f_2 and f_3 , *Figure 12*, is established by the ratio of R_1 to the input resistance of the amplifier (150 k Ω).

$$\text{Mid-band Gain} = \frac{R_1 + 150 \text{ k}\Omega}{150 \text{ k}\Omega} \quad (3)$$



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* For Stability with High Current Loads

FIGURE 13. RIAA Phono Amplifier

Capacitor C_1 sets the corner frequency f_2 where $R_1 = X_{C1}$.

$$C_1 = \frac{1}{2\pi f_2 R_1} \quad (4)$$

Capacitor C_2 establishes the corner frequency f_3 where X_{C2} equals the impedance of the inverting input. This is normally 150 kΩ. However, in the circuit of *Figure 13* negative feedback reduces the impedance at the inverting input as:

$$Z = \frac{Z_o}{1 + A_o\beta} \quad (5)$$

Where:

Z_o = impedance at node 6 without external feedback (150 kΩ)

A_o = gain without external feedback (50)

β = feedback transfer function $\beta = \frac{A_o - A}{A_o A}$

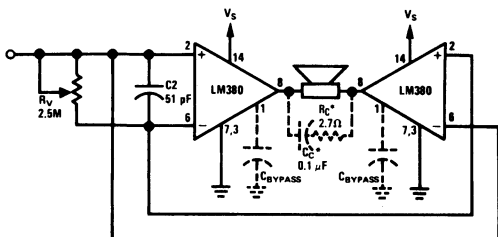
A = closed loop gain with external feedback.

Therefore

$$C_2 = \frac{1}{2\pi f_3 \left(\frac{Z_o}{1 + A_o\beta} \right)} = \frac{1}{2\pi f_3 \left(\frac{150\text{k}}{1 + 50\beta} \right)} \quad (6)$$

BRIDGE AMPLIFIER

Where more power is desired than can be provided with one amplifier, two amps may be used in the bridge configuration shown in *Figure 14*.



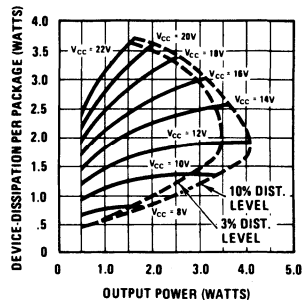
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*For Stability with High Current Loads

FIGURE 14. Bridge Configuration

This provides twice the voltage swing across the load for a given supply, thereby, increasing the power capability by a

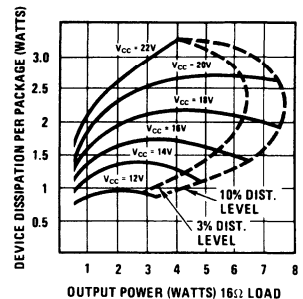
factor of four over the single amplifier. However, in most cases the package dissipation will be the first parameter limiting power delivered to the load. When this is the case, the power capability of the bridge will be only twice that of



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FIGURE 15A. 8Ω Load

the single amplifier. *Figures 15A and B* show output power versus device package dissipation for both 8 and 16Ω loads in the bridge configuration. The 3% and 10% harmonic

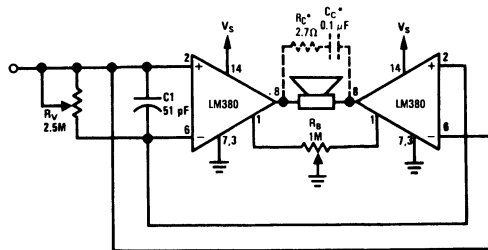


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FIGURE 15B. 16Ω Load

distortion contours double back due to the thermal limiting of the LM380. Different amounts of heat sinking will change the point at which the distortion contours bend.

The quiescent output voltage of the LM380 is specified at 9 ± 1 volts with an 18 volt supply. Therefore, under the worst case condition, it is possible to have two volts DC across the load.

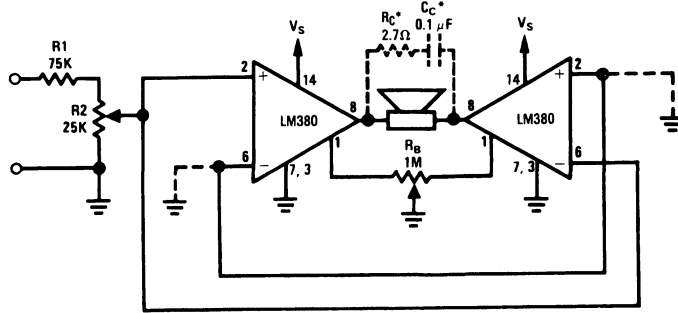


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*For Stability with High Current Loads

FIGURE 16. Quiescent Balance Control

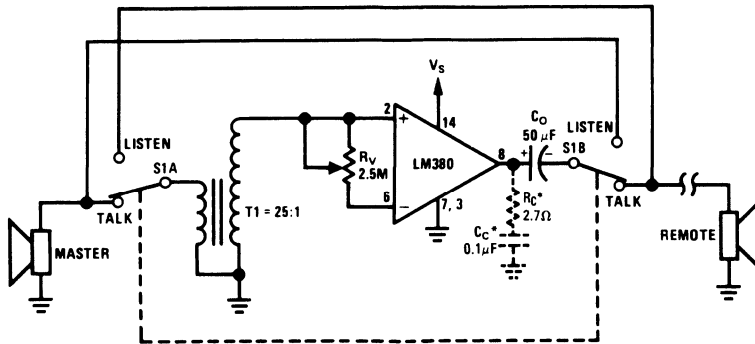
With an 8Ω speaker this 0.25A which may be excessive. Three alternatives are available; 1) care can be taken to match the quiescent voltages, 2) a non-polar capacitor may be placed in series with the load, 3) the offset balance control of *Figure 16* may be used.



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*For Stability with High Current Loads

FIGURE 17. Voltage Divider Input



TL/H/7380-21

*For Stability with High Current Loads

FIGURE 18. Intercom

The circuits of *Figures 14 and 16* employ the "common mode" volume control as shown before. However, any of the various input connection schemes discussed previously may be used. *Figure 17* shows the bridge configuration with the voltage divider input. As discussed in the "Biasing" section the undriven input may be AC or DC grounded. If V_S is an appreciable distance from the power supply ($>3''$) filter capacitor it should be decoupled with a $1\ \mu\text{F}$ tantalum capacitor.

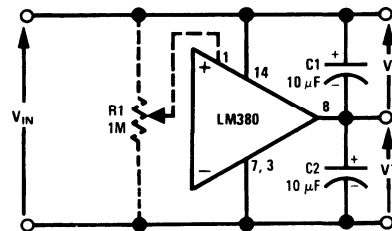
INTERCOM

The circuit of *Figure 18* provides a minimum component intercom. With switch S_1 in the talk position, the speaker of the master station acts as the microphone with the aid of step-up transformer T_1 .

A turns ratio of 25 and a device gain of 50 allows a maximum loop gain of 1250. R_V provides a "common mode" volume control. Switching S_1 to the listen position reverses the role of the master and remote speakers.

LOW COST DUAL SUPPLY

The circuit shown in *Figure 19* demonstrates a minimum parts count method of symmetrically splitting a supply voltage. Unlike the normal R, C, and power zener diode tech-



TL/H/7380-22

FIGURE 19. Dual Supply

nique the LM380 circuit does not require a high standby current and power dissipation to maintain regulation.

With a 20 volt input voltage (± 10 volt output) the circuit exhibits a change in output voltage of approximately 2% per 100 mA of unbalanced load change. Any balanced load change will reflect only the regulation of the source voltage V_{IN} .

The theoretical plus and minus output tracking ability is 100% since the device will provide an output voltage at one-half of the instantaneous supply voltage in the absence of a capacitor on the bypass terminal. The actual error in

tracking will be directly proportional to the unbalance in the quiescent output voltage. An optional potentiometer may be placed at pin 1 as shown in *Figure 19* to null output offset. The unbalanced current output for the circuit of *Figure 18* is limited by the power dissipation of the package.

In the case of sustained unbalanced excess loads, the device will go into thermal limiting as the temperature sensing circuit begins to function. For instantaneous high current loads or short circuits the device limits the output current to approximately 1.3 amperes until thermal shut-down takes over or until the fault is removed.

HIGH INPUT IMPEDANCE CIRCUIT

The junction FET isolation circuit shown in *Figure 20* raises the input impedance to 22 M Ω for low frequency input signals. The gate to drain capacitance (2 pF maximum for the KE4221 shown) of the FET limits the input impedance as frequency increases.

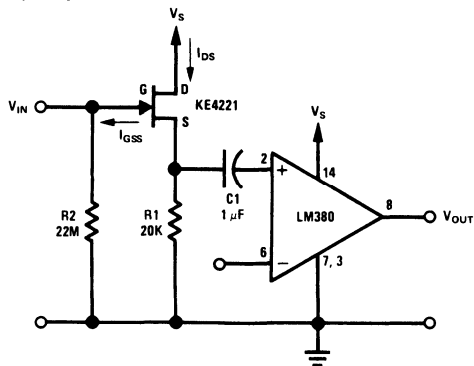


FIGURE 20

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At 20 kHz the reactance of this capacitor is approximately $-j4 \text{ M}\Omega$ giving a net input impedance magnitude of 3.9 M Ω . The values chosen for R_1 , R_2 and C_1 provide an overall circuit gain of at least 45 for the complete range of parameters specified for the KE4221.

When using another FET device the relevant design equations are as follows:

$$A_V = \left(\frac{R_1}{R_1 + \frac{1}{g_m}} \right) \quad (7)$$

$$g_m = g_{m0} \left(1 - \frac{V_{GS}}{V_P} \right) \quad (8)$$

$$V_{GS} = I_{DS} R_1 \quad (9)$$

$$I_{DS} = I_{DSS} \left(1 - \frac{V_{GS}}{V_P} \right)^2 \quad (10)$$

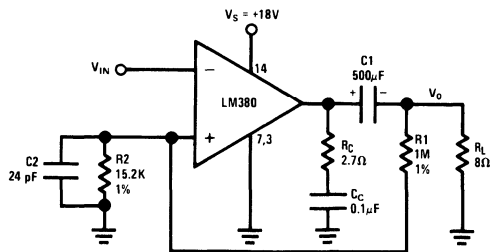
The maximum value of R_2 is determined by the product of the gate reverse leakage I_{GSS} and R_2 . This voltage should be 10 to 100 times smaller than V_P . The output impedance of the FET source follower is:

$$R_O = \frac{1}{g_m} \quad (11)$$

so that the determining resistance for the interstage RC time constant is the input resistance of the LM380.

BOOSTED GAIN USING POSITIVE FEEDBACK

For applications requiring gains higher than the internally set gain of 50, it is possible to apply positive feedback around the LM380 for closed loop gains of up to 300. *Figure 21* shows a practical example of an LM380 in a gain of 200 circuit.



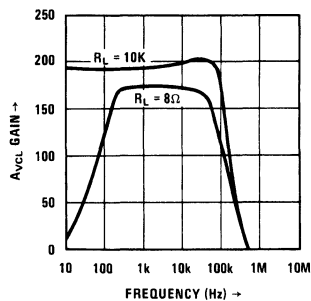
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FIGURE 21. Boosted Gain of 200 Using Positive Feedback

The equation describing the closed loop gain is:

$$A_{VCL} = \frac{-A_V(\omega)}{1 - \frac{A_V(\omega)}{1 + \frac{R_1}{R_2}}} \quad (12)$$

where $A_V(\omega)$ is complex at high frequencies but is nominally the 40 to 60 specified on the data sheet for the pass band of the amplifier. If $1 + R_1/R_2$ approaches the value of $A_V(\omega)$, the denominator of equation 12 approaches zero, the closed loop gain increases toward infinity, and the circuit oscillates. This is the reason for limiting the closed loop gain values to 300 or less. *Figure 22* shows the loaded and unloaded bode plot for the circuit shown in *Figure 21*.



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FIGURE 22. Boosted Gain Bode Plot

The 24 pF capacitor C_2 shown on *Figure 21* was added to give an overdamped square wave response under full load conditions. It causes a high frequency roll-off of:

$$f_2 = \frac{1}{2\pi R_2 C_2} \quad (13)$$

The circuit of *Figure 21* will have a very long (1000 sec) turn on time if R_L is not present, but only a 0.01 second turn on time with an 8 Ω load.

Micropower Circuits Using the LM4250 Programmable Op Amp

National Semiconductor
Application Note 71
George Cleveland



INTRODUCTION

The LM4250 is a highly versatile monolithic operational amplifier. A single external programming resistor determines the quiescent power dissipation, input offset and bias currents, slew rate, gain-bandwidth product, and input noise characteristics of the amplifier. Since the device is in effect a different op amp for each externally programmed set current, it is possible to use a single stock item for a variety of circuit functions in a system.

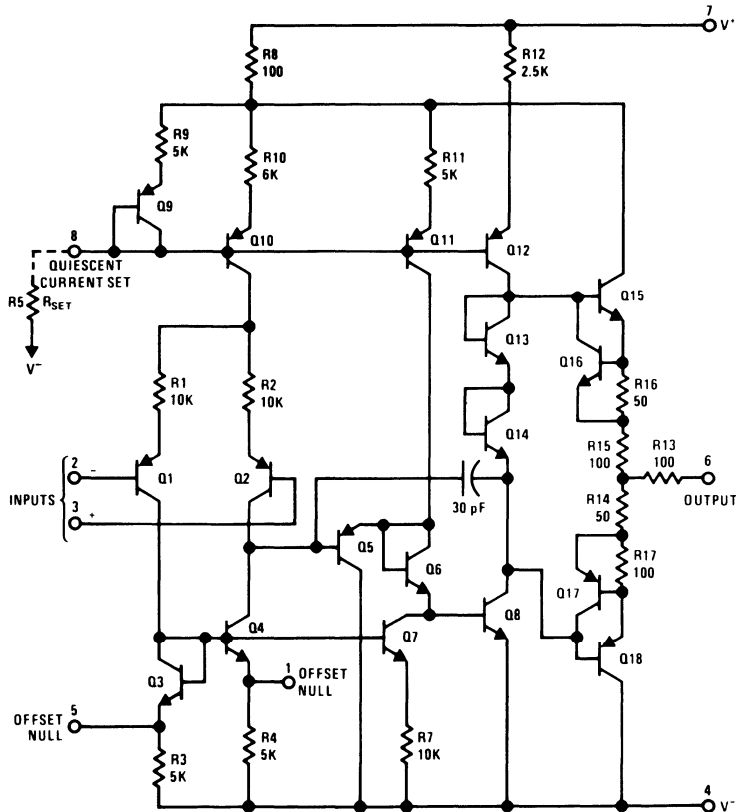
This paper describes the circuit operation of the LM4250, various methods of biasing the device, frequency response considerations, and some circuit applications exercising the unique characteristics of the LM4250.

CIRCUIT DESCRIPTION LM4250

The LM4250 has two special features when compared with other monolithic operational amplifiers. One is the ability to externally set the bias current levels of the amplifiers, and the other is the use of PNP transistors as the differential input pair.

Referring to *Figure 1*, Q_1 and Q_2 are high current gain lateral PNPs connected as a differential pair. R_1 and R_2 provide emitter degeneration for greater stability at high bias currents. Q_3 and Q_4 are used as active loads for Q_1 and Q_2 to provide high gain and also form a current inverter to provide the maximum drive for the single ended output into Q_5 . Q_5 is an emitter follower which prevents loading of the input stage by the succeeding amplifier stage.

One advantage of this lateral PNP input stage is a common mode swing to within 200 mV of the negative supply. This feature is especially useful in single supply operation with signals referred to ground. Another advantage is the almost constant input bias current over a wide temperature range. The input resistance R_{IN} is approximately equal to $2\beta(R_E + r_e)$ where β is the current gain, r_e is the emitter resistance of one of the input lateral PNPs, and R_E is the resistance of one of the 10 k Ω emitter resistor. Using a DC beta of 100 and the normal temperature dependent expression for r_e gives:



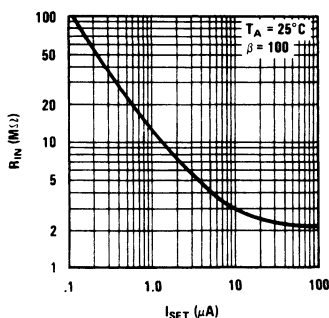
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FIGURE 1. LM4250 Schematic Diagram

$$R_{IN} \approx 2 \text{ M}\Omega + 2 \frac{kT}{qI_B} \quad (1)$$

where I_B is input bias current. At room temperature this formula becomes:

$$R_{IN} \approx 2 \text{ M}\Omega + \frac{52 \text{ mV}}{I_B} \quad (2)$$



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FIGURE 2. Input Resistance vs I_{SET}

Figure 2 gives a typical plot of R_{IN} vs I_{set} derived from the above equation.

Continuing with the circuit description, Q_6 level shifts downward to the base of Q_8 which is the second stage amplifier. Q_8 is run as a common emitter amplifier with a current source load (Q_{12}) to provide maximum gain. The output of Q_8 drives the class B complementary output stage composed of Q_{15} and Q_{18} .

The bias current levels in the LM4250 are set by the amount of current (I_{set}) drawn out of Pin 8. The constant current sources Q_{10} , Q_{11} , and Q_{12} are controlled by the amount of I_{set} current through the diode connected transistor Q_9 and resistor R_9 . The constant collector current from Q_{10} biases the differential input stage. Therefore, the level Q_{10} is set at will control such amplifier characteristics as input bias current, input resistance, and amplifier slew rate. Current source Q_{11} biases Q_5 and Q_6 . The current ratio between Q_5 and Q_6 is controlled by constant current sink Q_7 . Current source Q_{12} sets the currents in diodes Q_{13} and Q_{14} which bias the output stage to the verge of conduction thereby eliminating the dead zone in the class B output. Q_{12} also acts as the load for Q_8 and limits the drive current to Q_{15} .

The output current limiting is provided by Q_{16} and Q_{17} and their associated resistors R_{16} and R_{17} . When enough current is drawn from the output, Q_{16} turns on and limits the base drive of Q_{15} . Similarly Q_{17} turns on when the LM4250 attempts to sink too much current, limiting the base drive of Q_{18} and therefore output current. Frequency compensation is provided by the 30 pF capacitor across the second stage amplifier, Q_8 , of the LM4250. This provides a 6 dB per octave rolloff of the open loop gain.

BIAS CURRENT SETTING PROCEDURE

The single set resistor shown in Figure 3a offers the most straightforward method of biasing the LM4250. When the set resistor is connected from Pin 8 to ground the resistance value for a given set current is:

$$R_{SET} = \frac{V^+ - 0.5}{I_{SET}} \quad (3)$$

The 0.5 volts shown in Equation 3 is the voltage drop of the master bias current diode connected transistor on the inte-

grated circuit chip. In applications where the regulation of the V^+ supply with respect to the V^- supply (as in the case of tracking regulators) is better than the V^+ supply with respect to ground the set resistor should be connected from Pin 8 to V^- . R_{SET} is then:

$$R_{SET} = \frac{V^+ + |V^-| - 0.5}{I_{SET}} \quad (4)$$

The transistor and resistor scheme shown in Figure 3b allows one to switch the amplifier off without disturbing the main V^+ and V^- power supply connections. Attaching C_1 across the circuit prevents any switching transient from appearing at the amplifier output. The dual scheme shown in Figure 3c has a constant set current flowing through R_{S1} and a variable current through R_{S2} . Transistor Q_2 acts as an emitter follower current sink whose value depends on the control voltage V_c on the base. This circuit provides a meth-

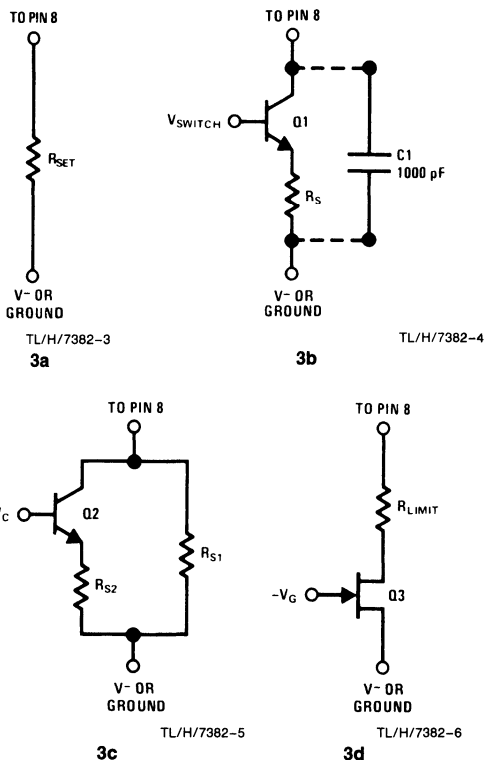


FIGURE 3. Biasing Schemes

od of varying the amplifier's characteristics over a limited range while the amplifier is in operation. The FET circuit shown in Figure 3d covers the full range of set currents in response to as little as a 0.5V gate potential change on a low pinch-off voltage FET such as the 2N3687. The limit resistor prevents excessive current flow out of the LM4250 when the FET is fully turned on.

FREQUENCY RESPONSE OF A PROGRAMMABLE OP AMP

This section provides a method of determining the sine and step voltage response of a programmable op amp. Both the sine and step voltage responses of an amplifier are modified when the rate of change of the output voltage reaches the slew rate limit of the amplifier. The following analysis devel-

ops the Bode plot as well as the small signal and slew rate limited responses of an amplifier to these two basic categories of waveforms.

SMALL SIGNAL SINE WAVE RESPONSE

The key to constructing the Bode plot for a programmable op amp is to find the gain bandwidth product, GBWP, for a given set current. Quiescent power drain, input bias current, or slew rate considerations usually dictate the desired set current. The data sheet curve relating GBWP to set current provides the value of GBWP which when divided by one yields the unity gain crossover of f_u . Assuming a set current of $6 \mu A$ gives a GBWP of 200,000 Hz and therefore an f_u of 200 kHz for the example shown in Figure 4. Since the device has a single dominant pole, the rolloff slope is -20 dB of gain per decade of frequency (-6 dB/octave). The dotted line shown on Figure 4 has this slope and passes

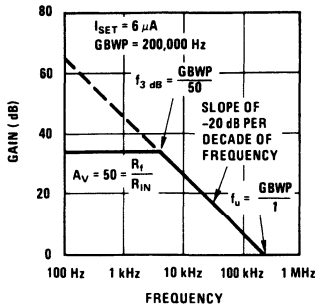


FIGURE 4. Bode Plot

through the 200 kHz f_u point. Arbitrarily choosing an inverting amplifier with a closed loop gain magnitude of 50 determines the height of the 34 dB horizontal line shown in Figure 4. Graphically finding the intersection of the sloped line and the horizontal line or mathematically dividing GBWP by 50 determines the 3 dB down frequency of 4 kHz for the closed loop response of this amplifier configuration. Therefore, the amplifier will now apply a gain of -50 to all small signal sine waves at frequencies up to 4 kHz. For frequencies above 4 kHz, the gain will be as shown on the sloped portion of the Bode plot.

SMALL SIGNAL STEP INPUT RESPONSE

The amplifier's response to a positive step voltage change at the input will be an exponentially rising waveform whose rise time is a function of the closed loop 3 dB down bandwidth of the amplifier. The amplifier may be modeled as a single pole low pass filter followed by a gain of 50 wideband amplifier. From basic filter theory*, the 10% to 90% rise time of a single pole low pass filter is:

$$t_r = \frac{0.35}{f_{3\text{ dB}}} \quad (5)$$

For the example shown in Figure 4 the 4 kHz 3 dB down frequency would give a rise time of 87.5 μs .

SLEW RATE LIMITED LARGE SIGNAL RESPONSE

The final consideration, which determines the upper speed limitation on the previous two types of signal responses, is the amplifier slew rate. The slew rate of an amplifier is the maximum rate of change of the output signal which the amplifier is capable of delivering. In the case of sinusoidal signals, the maximum rate of change occurs at the zero crossing and may be derived as follows:

*See reference.

$$V_O = V_p \sin 2\pi f t \quad (6)$$

$$\frac{dV_O}{dt} = 2\pi f V_p \cos 2\pi f t \quad (7)$$

$$\left. \frac{dV_O}{dt} \right|_{t=0} = 2\pi f V_p \quad (8)$$

$$S_r = 2\pi f_{\text{MAX}} V_p \quad (9)$$

where:

V_O = output voltage

V_p = peak output voltage

S_r = maximum $\frac{dV_O}{dt}$

The maximum sine wave frequency an amplifier with a given slew rate will sustain without causing the output to take on a triangular shape is therefore a function of the peak amplitude of the output and is expressed as:

$$f_{\text{MAX}} = \frac{S_r}{2\pi V_p} \quad (10)$$

Figure 5 shows a quick reference graphical presentation of this formula with the area below any V_{peak} line representing an undistorted small signal sine wave response for a given frequency and amplifier slew rate and the area above the V_{peak} line representing a distorted sine wave response due to slew rate limiting for a sine wave with the given V_{peak} .

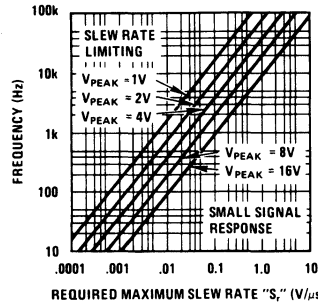


FIGURE 5. Frequency vs Slew Rate Limit vs Peak Output Voltage

Large signal step voltage changes at the output will have a rise time as shown in equation 5 until a signal with a rate of output voltage change equal to the slew rate of the amplifier occurs. At this point the output will become a ramp function with a slope equal to S_r . This action occurs when:

$$S_r \leq \frac{V_{\text{step}}}{t_r} \quad (11)$$

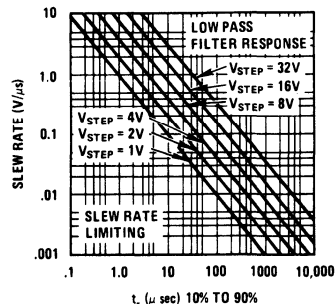


FIGURE 6. Slew Rate vs Rise Time vs Step Voltage

Figure 6 graphically expresses this formula and shows the maximum amplitude of undistorted step voltage for a given slew rate and rise time. The area above each step voltage line represents the undistorted low pass filter type response mode of the amplifier. If the intersection of the rise time and slew rate values of a particular amplifier configuration falls below the expected step voltage amplitude line, the rise time will be determined by the slew rate of the amplifier. The rise time will then be equal to the amplitude of the step divided by the slew rate S_r .

FULL POWER BANDWIDTH

The full power bandwidth often found on amplifier specification sheets is the range of frequencies from zero to the frequency found at the intersection on Figure 5 of the maximum rated output voltage and the slew rate S_r of the amplifier. Mathematically this is:

$$f_{\text{full power}} = \frac{S_r}{2\pi V_{\text{rated}}} \quad (12)$$

The full power bandwidth of a programmable amplifier such as the LM4250 varies with the master bias set current.

The above analysis of sine wave and step voltage amplifier responses applies for all single dominant pole op amps such as the LM101A, LM1107, LM108A, LM112, LM118, and LM741 as well as the LM4250 programmable op amp.

500 MANO-WATT X10 AMPLIFIER

The X10 inverting amplifier shown in Figure 7 demonstrates the low power capability of the LM4250 at extremely low values of supply voltage and set current. The circuit draws 260 nA from the +1.0V supply of which 50 nA flows through the 12 M Ω set resistor. The current into the -1.0V supply is only 210 nA since the set resistor is tied to ground rather than V^- . Total quiescent power dissipation is:

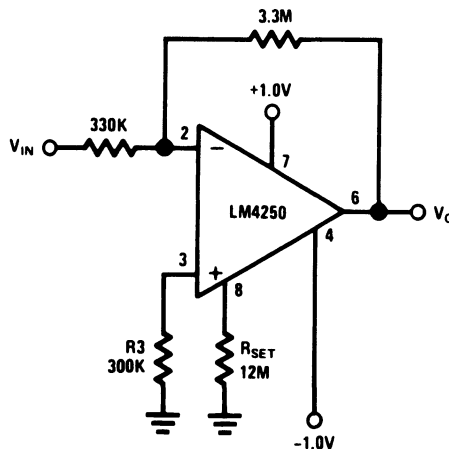
$$P_D = (260 \text{ nA})(1\text{V}) + (210 \text{ nA})(1\text{V}) \quad (13)$$

$$P_D = 470 \text{ nW} \quad (14)$$

The slew rate determined from the data sheet typical performance curve is 1 V/ms for a .05 μA set current. Samples of actual values observed were 1.2 V/ms for the negative slew rate and 0.85 V/ms for the positive slew rate. This difference occurs due to the non-symmetry in the current sources used for charging and discharging the internal 30 pF compensation capacitor.

The 3 dB down (gain of -7.07) frequency observed for this configuration was approximately 300 Hz which agrees fairly closely with the 3.5 kHz GBWP divided by 10 taken from an extrapolation of the data sheet typical GBWP versus set current curve.

Peak-to-peak output voltage swing into a 100 k Ω load is 0.7V or $\pm 0.35\text{V}$ peak. An increase in supply voltage to $\pm 1.35\text{V}$ such as delivered by a pair of mercury cells directly increases the output swing by $\pm 0.35\text{V}$ to 1.4V peak-to-peak. Although this increases the power dissipation to approximately 1 μW per battery, a power drain of 15 μW or less will not affect the shelf life of a mercury cell.

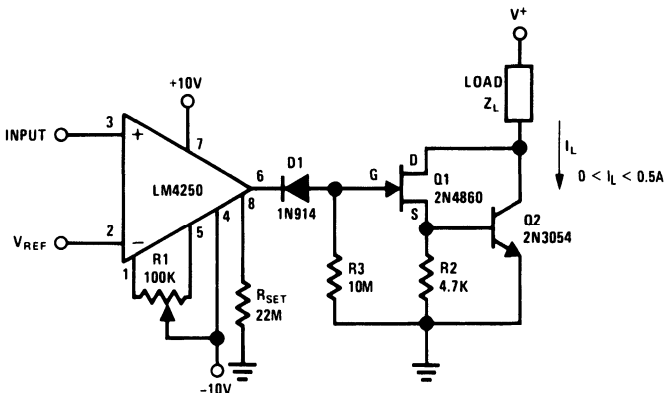


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FIGURE 7. 500 nW x 10 Amplifier

MICRO-POWER MONITOR WITH HIGH CURRENT SWITCH

Figure 8 shows the combination of a micro-power comparator and a high current switch run from a separate supply. This circuit provides a method of continuously monitoring an input voltage while dissipating only 100 μW of power and still being capable of switching a 500 mA load if the input exceeds a given value. The reference voltage can be any value between +8.5V and -8.5V. With a minimum gain of approximately 100,000 the comparator can resolve input voltage differences down into the 0.2 mV region.



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FIGURE 8. μ -Power Comparator with High Current Switch

The bias current for the LM4250 shown in *Figure 8* is set at $0.44 \mu\text{A}$ by the $200 \text{ M}\Omega$ R_{set} resistor. This results in a total comparator power drain of $100 \mu\text{W}$ and a slew rate of approximately 11 V/ms in the positive direction and 12.8 V/ms in the negative direction. Potentiometer R_1 provides input offset nulling capability for high accuracy applications. When the input voltage is less than the reference voltage, the output of the LM4250 is at approximately -9.5V causing diode D_1 to conduct. The gate of Q_1 is held at -8.8V by the voltage developed across R_3 . With a large negative voltage on the gate of Q_1 it turns off and removes the base drive from Q_2 . This results in a high voltage or open switch condition at the collector of Q_2 . When the input voltage exceeds the reference voltage, the LM4250 output goes to $+9.5\text{V}$ causing D_1 to be reverse biased. Q_1 turns on as does Q_2 , and the collector of Q_2 drops to approximately 1V while sinking the 500 mA of load current.

The load denoted as Z_L can be resistor, relay coil, or indicator lamp as required; but the load current should not exceed 500 mA . For V^+ values of less than 15V and I_L values of less than 25 mA both Q_2 and R_2 may be omitted. With only the 2N4860 JFET as an output device the circuit is still capable of driving most common types of indicator lamps.

IC METER AMPLIFIER RUNS ON TWO FLASHLIGHT BATTERIES

Meter amplifiers normally require one or two 9V transistor batteries. Due to the heavy current drain on these supplies, the meters must be switched to the OFF position when not in use. The meter circuit described here operates on two 1.5V flashlight batteries and has a quiescent power drain so low that no ON-OFF switch is needed. A pair of Eveready No. 950 "D" cells will serve for a minimum of one year without replacement. As a DC ammeter, the circuit will provide current ranges as low as 100 nA full-scale.

The basic meter amplifier circuit shown in *Figure 9* is a current-to-voltage converter. Negative feedback around the amplifier insures that currents I_{IN} and I_f are always equal, and the high gain of the op amp insures that the input voltage between Pins 2 and 3 is in the microvolt region. Output

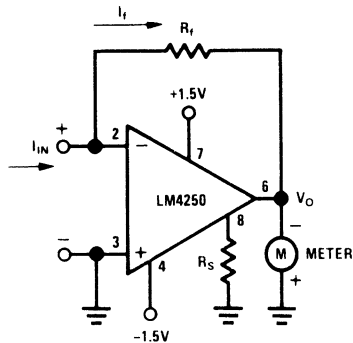
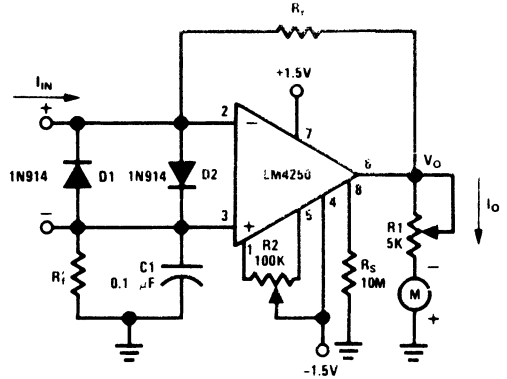


FIGURE 9. Basic Meter Amplifier

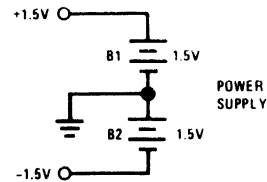
voltage V_O is therefore equal to $-I_f R_f$. Considering the $\pm 1.5\text{V}$ sources ($\pm 1.2\text{V}$ end-of-life) a practical value of V_O for full scale meter deflection is 300 mV . With the master bias-current setting resistor (R_3) set at $10 \text{ M}\Omega$, the total quiescent current drain of the circuit is $0.6 \mu\text{A}$ for a total power supply drain of $1.8 \mu\text{W}$. The input bias current, required by the amplifier at this low level of quiescent current, is in the range of 600 pA .

THE COMPLETE NANOAMMETER

The complete meter amplifier shown in *Figure 10* is a differential current-to-voltage converter with input protection, zeroing and full scale adjust provisions, and input resistor balancing for minimum offset voltage. Resistor R'_f (equal in value to R_f for measurements of less than $1 \mu\text{A}$) insures that the input bias currents for the two input terminals of the amplifier do not contribute significantly to an output error voltage. The output voltage V_O for the differential current-to-voltage converter is equal to $-2 I_f R_f$ since the floating input current I_{IN} must flow through R_f and R'_f . R'_f may be omitted



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TL/H/7382-14

FIGURE 10. Complete Meter Amplifier

Resistance Values for DC Nano and Micro Ammeter

I FULL SCALE	$R_f [\Omega]$	$R'_f [\Omega]$
100 nA	1.5M	1.5M
500 nA	300k	300k
1 μA	300k	0
5 μA	60k	0
10 μA	30k	0
50 μA	6k	0
100 μA	3k	0

for R_f values of $500 \text{ k}\Omega$ or less, since a resistance of this value contributes an error of less than 0.1% in output voltage. Potentiometer R_2 provides an electrical meter zero by forcing the input offset voltage V_{OS} to zero. Full scale meter deflection is set by R_1 . Both R_1 and R_2 only need to be set once for each op amp and meter combination. For a 50 microamp $2 \text{ k}\Omega$ meter movement, R_1 should be about $4 \text{ k}\Omega$ to give full scale meter deflection in response to a 300 mV output voltage. Diodes D_1 and D_2 provide full input protection for overcurrents up to 75 mA .

With an R_f resistor value of 1.5M the circuit in *Figure 10* becomes a nanometer with a full scale reading capability

of 100 nA. Reducing R_f to 3 k Ω in steps, as shown in *Figure 10* increases the full scale deflection to 100 μ A, the maximum for this circuit configuration. The voltage drop across the two input terminals is equal to the output voltage V_o divided by the open loop gain. Assuming an open loop gain of 10,000 gives an input voltage drop of 30 μ V or less.

CIRCUIT FOR HIGHER CURRENT READINGS

For DC current readings higher than 100 μ A, the inverting amplifier configuration shown in *Figure 11* provides the required gain. Resistor R_A develops a voltage drop in response to input current I_A . This voltage is amplified by a factor equal to the ratio of R_f/R_B . R_B must be sufficiently larger than R_A , so as not to load the input signal. *Figure 11* also shows the proper values of R_A , R_B and R_f for full scale meter deflections of from 1 mA to 10A.

Resistance Values for DC Ammeter

I FULL SCALE	R_A [Ω]	R_B [Ω]	R_f [Ω]
1 mA	3.0	3k	300k
10 mA	.3	3k	300k
100 mA	.3	30k	300k
1A	.03	30k	300k
10A	.03	30k	30k

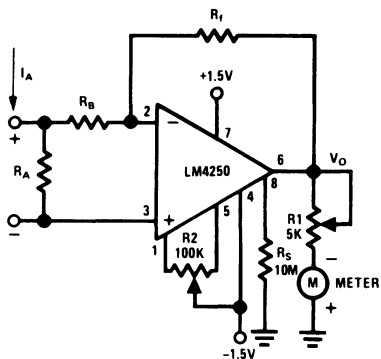


FIGURE 11. Ammeter

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A 10 mV TO 100V FULL-SCALE VOLTMETER

A resistor inserted in series with one of the input leads of the basic meter amplifier converts it to a wide range voltmeter circuit, as shown in *Figure 12*. This inverting amplifier has a gain varying from -30 for the 10 mV full scale range to -0.003 for the 100V full scale range. *Figure 12* also lists the proper values of R_V , R_f , and R'_f for each range. Diodes D_1 and D_2 provide complete amplifier protection for input overvoltages as high as 500V on the 10 mV range, but if overvoltages of this magnitude are expected under continuous operation, the power rating of R_V should be adjusted accordingly.

Resistance Values for a DC Voltmeter

V FULL SCALE	R_V [Ω]	R_f [Ω]	R'_f [Ω]
10 mV	100k	1.5M	1.5M
100 mV	1M	1.5M	1.5M
1V	10M	1.5M	1.5M
10V	10M	300k	0
100V	10M	30k	0

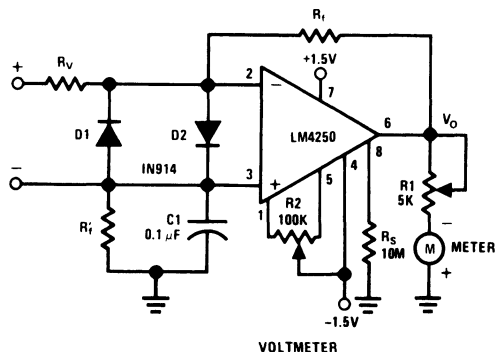


FIGURE 12. Voltmeter

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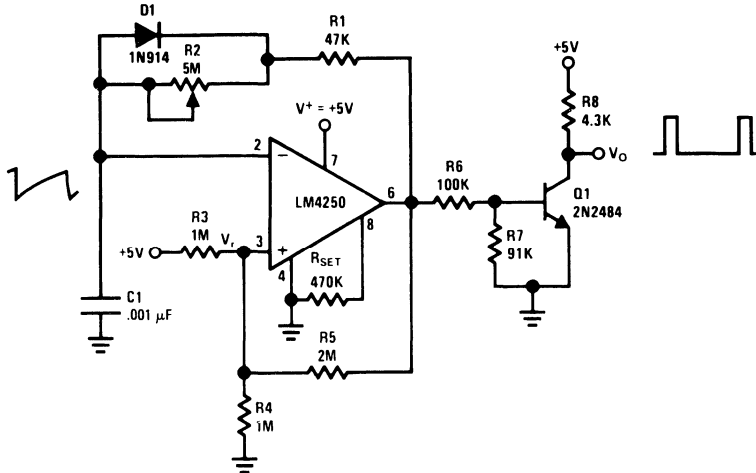


FIGURE 13. Pulse Generator

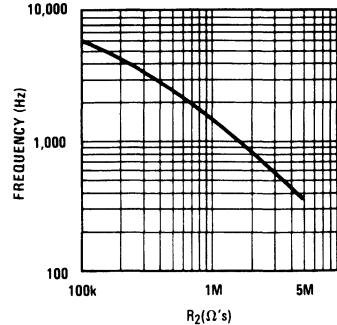
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LOW FREQUENCY PULSE GENERATOR USING A SINGLE +5V SUPPLY

The variable frequency pulse generator shown in *Figure 13* provides an example of the LM4250 operated from a single supply. The circuit is a buffered output free running multivibrator with a constant width output pulse occurring with a frequency determined by potentiometer R_2 .

The LM4250 acts as a comparator for the voltages found at the upper plate of capacitor C_1 and at the reference point denoted as V_r on *Figure 13*. Capacitor C_1 charges and discharges with a peak-to-peak amplitude of approximately 1V determined by the shift in reference voltage V_r at Pin 3 of the op amp. The charge path of C_1 is from the amplifier output, which is at its maximum positive voltage V_{HIGH} (approximately $V^+ - 0.5V$), through R_1 and through the potentiometer R_2 . Diode D_1 is reverse biased during the charge period. When C_1 charges to the V_r value determined by the net result of V_{HIGH} through resistor R_5 and V^+ through the voltage divider made up of resistors R_3 and R_4 the amplifier swings to its lower limit of approximately 0.5V causing C_1 to begin discharging. The discharge path is through the forward biased diode D_1 , through resistor R_1 , and into Pin 6 of the op amp. Since the impedance in the discharge path does not vary for R_2 settings of from 3 k Ω to 5 M Ω , the output pulse maintains a constant pulse width of 41 $\mu s \pm 1.5 \mu s$ over this range of potentiometer settings. *Figure 14* shows the output pulse frequency variation from 6 kHz down to 360 Hz as R_2 places from 100 k Ω up to 5 M Ω of additional resistance in the charge path of C_1 . Setting R_2 to zero ohms will short out diode D_1 and cause a symmetrical square wave output at a frequency of 10 kHz. Increasing the value of C_1 will lower the range of frequencies available in response to the R_2 variation shown on *Figure 14*. Electrolytic capacitors may be used for the larger values of C_1 since it has only positive voltages applied to it.

The output buffer Q_1 presents a constant load to the op amp output thereby preventing frequency variations caused by V_{HIGH} and V_{LOW} voltages changing as a function of load current. The output of Q_1 will interface directly with a standard TTL or DTL logic device. Reversing diode D_1 will invert the polarity of the generator output providing a series of negative going pulses dropping from +5V to the saturation voltage of Q_1 .

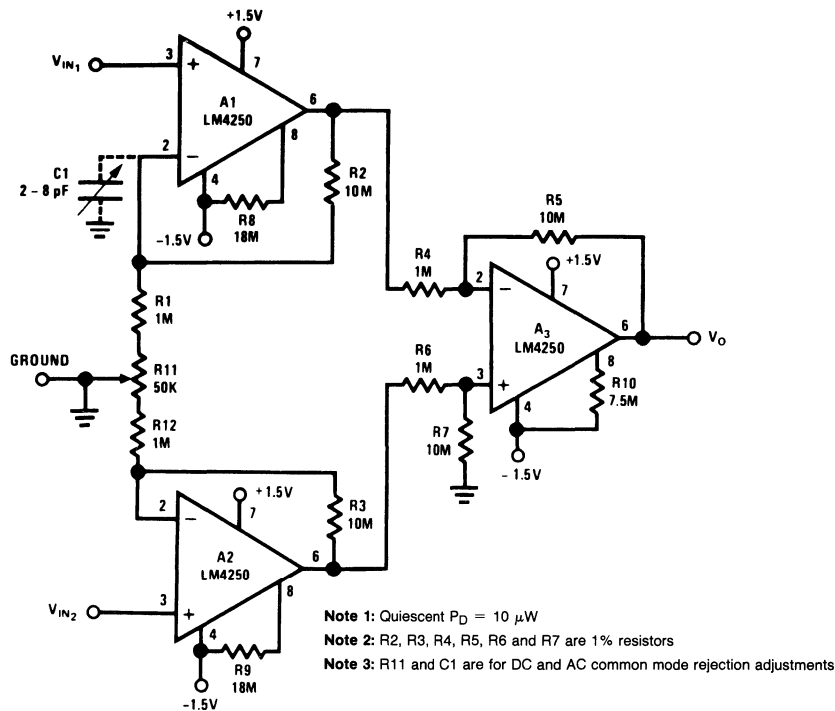


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FIGURE 14. Pulse Frequency vs R_2

The change in output frequency as a function of supply voltage is less than $\pm 4\%$ for a V^+ change of from 4V to 10V. This stability of frequency versus supply voltage is due to the fact that the reference voltage V_r and the drive voltage for the capacitor are both direct functions of V^+ .

The power dissipation of the free running multivibrator is 300 μW and the power dissipation of the buffer circuit is approximately 5.8 mW.

FIGURE 15. $\times 100$ Instrumentation Amplifier

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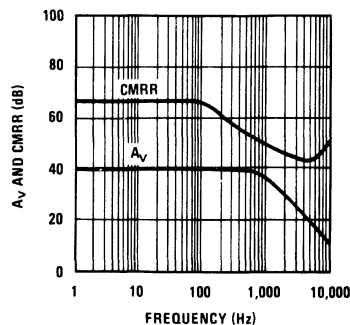
X100 INSTRUMENTATION AMPLIFIER

The instrumentation amplifier circuit shown in *Figure 15* has a full differential input center tapped to ground. With the bias current set at approximately $0.1 \mu A$, the impedance looking into either V_{IN1} or V_{IN2} is $100 M\Omega$ with respect to ground, and the input bias current at either terminal is $0.2 nA$. The two non-inverting input stages A_1 and A_2 apply a gain of 10 to the input signal, and the differential output stage applies an additional gain of -10 for a net amplifier gain of -100 :

$$V_O = -100(V_{IN1} - V_{IN2}). \quad (15)$$

The entire circuit can run from two 1.5V batteries connected directly to the V^+ and V^- terminals. With a total current drain of $2.8 \mu A$ the quiescent power dissipation of the circuit is $8.4 \mu W$. This is low enough to have no significant effect on the shelf life of most batteries.

Potentiometer R_{11} provides a means for matching the gains of A_1 and A_2 to achieve maximum DC common mode rejection ratio CMRR. With R_{11} adjusted to its null point for DC common mode rejection the small AC CMRR trimmer capacitor C_1 will normally give an additional 10 to 20 dB of CMRR over the operating frequency range. Since C_1 actually balances wiring capacitance rather than amplifier frequency characteristics, it may be necessary to attach it to Pin 2 of either A_1 or A_2 as required. *Figure 16* shows the variation of CMRR (referred to the input) with frequency for this configuration. Since the circuit applies a gain of 100 or 40 dB to an input signal, the actual observed rejection ratio



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FIGURE 16. A_V and CMRR vs Frequency

is the difference between the CMRR curve and A_V curve. For example, a 60 Hz common mode signal will be attenuated by 67 dB minus 40 db or 27 dB for an actual rejection ratio of V_{IN}/V_O equal to 22.4.

The maximum peak-to-peak output signal into a $100 k\Omega$ load resistor is approximately 1.8V. With no input signal, the noise seen at the output is approximately $0.8 mV_{RMS}$ or $8 \mu V_{RMS}$ referred to the input. When doing power dissipation measurements on this circuit, it should be kept in mind that even a $1 M\Omega$ oscilloscope probe placed between +1.5V and -1.5V will more than double the power drawn from the batteries.

5V REGULATOR FOR CMOS LOGIC CIRCUITS

The ideal regulator for low power CMOS logic elements should dissipate essentially no power when the CMOS devices are running at low frequencies, but be capable of delivering full output power on demand when the CMOS devices are running in the 0.1 MHz to 10 MHz region. With a 10V input voltage, the regulator shown in Figure 17 will dissipate $350 \mu\text{W}$ in the stand-by mode but will deliver up to 50 mA of continuous load current when required.

The circuit is basically a boosted output voltage-follower referenced to a low current zener diode. The voltage divider consisting of R_2 and R_3 provides a 5V tap voltage from the 6.5V reference diode to determine the regulator output. Since a standard 6.5V zener diode does not exhibit good regulation in the $2 \mu\text{A}$ to $60 \mu\text{A}$ reverse current region, Q_2 must be a special device. An NPN transistor with its collector and base terminals grounded and its emitter tied to the junction of R_1 and R_2 exhibits a well-controlled base emitter reverse breakdown voltage. A National Semiconductor process 25 small signal NPN transistor sorted to a

2N registration such as 2N3252 has a BV_{EBO} at $10 \mu\text{A}$ specified as 5.5V minimum, 6.5V typical, and 7.0V maximum. Using a diode connected 2N3252 as a reference, the regulator output voltage changed 78 mV in response to an 8V to 36V change in the input voltage. This test was done under both no load and full load conditions and represents a line regulation of better than 1.6%.

A load change from $10 \mu\text{A}$ to 50 mA caused a 1 mV change in output voltage giving a load regulation value of 0.05%. When operating the regulator at load currents of less than 25 mA, no heat sink is required for Q_1 . For load currents in excess of 50 mA, Q_1 should be replaced by a Darlington pair with the 2N3019 acting as a driver for a higher power device such as a 2N3054.

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Millman, J. and Halkias, C.C.: "Electronic Device and Circuits," pp. 465-466, McGraw-Hill Book Company, New York, 1967.

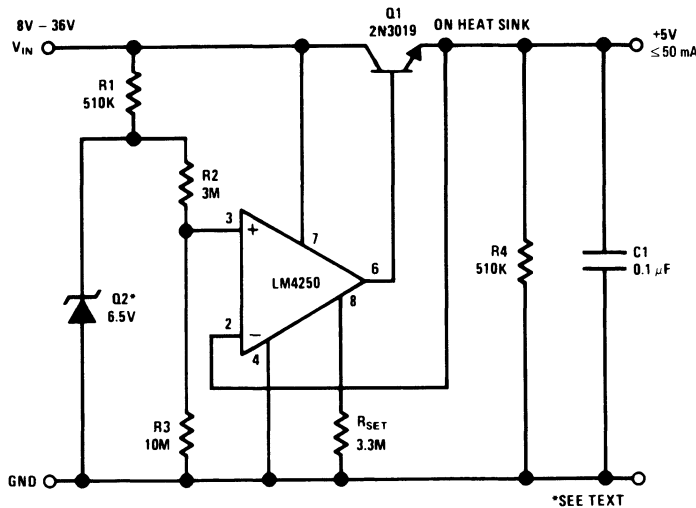


FIGURE 17. $350 \mu\text{W}$ Quiescent Drain 5 Volt Regulator

TL/H/7382-21

The LM3900: A New Current-Differencing Quad of \pm Input Amplifiers

National Semiconductor
Application Note 72
T. M. Frederiksen



AN-72

PREFACE

With all the existing literature on "how to apply op amps" why should another application note be produced on this subject? There are two answers to this question; 1) the LM3900 operates in quite an unusual manner (compared to a conventional op amp) and therefore needs some explanation to familiarize a new user with this product, and 2) the standard op amp applications assume a split power supply ($\pm 15 V_{DC}$) is available and our emphasis here is directed toward circuits for lower cost single power supply control systems. Some of these circuits are simply "re-biased" versions of conventional handbook circuits but many are new approaches which are made possible by some of the unique features of the LM3900.

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The LM3900: A New Current-Differencing Quad of \pm Input Amplifiers

1.0 An Introduction to the New "Norton" Amplifier

The LM3900 represents a departure from conventional amplifier designs. Instead of using a standard transistor differential amplifier at the input, the non-inverting input function has been achieved by making use of a "current-mirror" to "mirror" the non-inverting input current about ground and then to extract this current from that which is entering the inverting input terminal. Whereas the conventional op amp differences input voltages, this amplifier differences input currents and therefore the name "Norton Amp" has been used to indicate this new type of operation. Many biasing advantages are realized when operating with only a single power supply voltage. The fact that currents can be passed between the input terminals allows some unusual applications. If external, large valued input resistors are used (to convert from input voltages to input currents) most of the standard op amp applications can be realized.

Many industrial electronic control systems are designed that operate off of only a single power supply voltage. The conventional integrated-circuit operational amplifier (IC op amp) is typically designed for split power supplies (± 15 V_{DC}) and suffers from a poor output voltage swing and a rather large minimum common-mode input voltage range (approximately $+ 2$ V_{DC}) when used in a single power supply application. In addition, some of the performance characteristics of these op amps could be sacrificed—especially in favor of reduced costs.

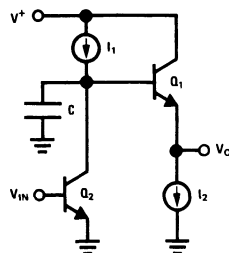
To meet the needs of the designers of low-cost, single-power-supply control systems, a new internally compensated amplifier has been designed that operates over a power supply voltage range of $+4$ V_{DC} to 36 V_{DC} with small changes in performance characteristics and provides an output peak-to-peak voltage swing that is only 1V less than the magnitude of the power supply voltage. Four of these amplifiers have been fabricated on a single chip and are provided in the standard 14-pin dual-in-line package.

The cost, application and performance advantages of this new quad amplifier will guarantee it a place in many single power supply electronic systems. Many of the "housekeeping" applications which are now handled by standard IC op amps can also be handled by this "Norton" amplifier operating off the existing ± 15 V_{DC} power supplies.

1.1 BASIC GAIN STAGE

The gain stage is basically a single common-emitter amplifier. By making use of current source loads, a large voltage gain has been achieved which is very constant over temperature changes. The output voltage has a large dynamic range, from essentially ground to one V_{BE} less than the power supply voltage. The output stage is biased class A for small signals but converts to class B to increase the load current which can be "absorbed" by the amplifier under large signal conditions. Power supply current drain is essentially independent of the power supply voltage and ripple on the supply line is also rejected. A very small input biasing current allows high impedance feedback elements to be used and even lower "effective" input biasing currents can be realized by using one of the amplifiers to supply essentially all of the bias currents for the other amplifiers by making use of the "matching" which exists between the 4 amplifiers which are on the same IC chip (see *Figure 84*).

The simplest inverting amplifier is the common-emitter stage. If a current source is used in place of a load resistor, a large open-loop gain can be obtained, even at low power-supply voltages. This basic stage (*Figure 1*) is used for the amplifier.



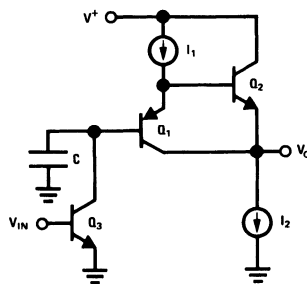
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FIGURE 1. Basic Gain Stage

All of the voltage gain is provided by the gain transistor, Q₂, and an output emitter-follower transistor, Q₁, serves to isolate the load impedance from the high impedance that exists at the collector of the gain transistor, Q₂. Closed-loop stability is guaranteed by an on-chip capacitor C = 3 pF, which provides the single dominant open-loop pole. The output emitter-follower is biased for class-A operation by the current source I₂.

This basic stage can provide an adequate open-loop voltage gain (70 dB) and has the desired large output voltage swing capability. A disadvantage of this circuit is that the DC input current, I_{IN}, is large; as it is essentially equal to the maximum output current, I_{OUT}, divided by β^2 . For example, for an output current capability of 10 mA the input current would be at least 1 μ A (assuming $\beta^2 = 10^4$). It would be desirable to further reduce this by adding an additional transistor to achieve an overall β^3 reduction. Unfortunately, if a transistor is added at the output (by making Q₁ a Darlington pair) the peak-to-peak output voltage swing would be somewhat reduced and if Q₂ were made a Darlington pair the DC input voltage level would be undesirably doubled.

To overcome these problems, a lateral PNP transistor has been added as shown in *Figure 2*. This connection neither reduces the output voltage swing nor raises the DC input voltage, but does provide the additional gain that was needed to reduce the input current.



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FIGURE 2. Adding a PNP Transistor to the Basic Gain Stage

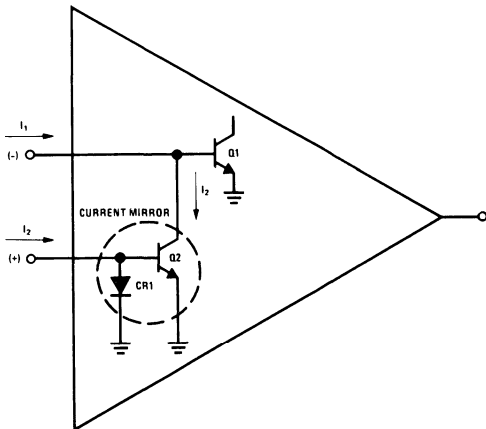
Notice that the collector of this PNP transistor, Q_1 , is connected directly to the output terminal. This "bootstraps" the output impedance of Q_1 and therefore reduces the loading at the high-impedance collector of the gain transistor, Q_3 .

In addition, the collector-base junction of the PNP transistor becomes forward biased under a large-signal negative output voltage swing condition. The design of this device has allowed Q_1 to convert to a vertical PNP transistor during this operating mode which causes the output to change from the class A bias to a class B output stage. This allows the amplifier to sink more current than that provided by the current source I_2 , (1.3 mA) under large signal conditions.

1.2 OBTAINING A NON-INVERTING INPUT FUNCTION

The circuit of *Figure 2* has only the inverting input. A general purpose amplifier requires two input terminals to obtain both an inverting and a non-inverting input. In conventional op amp designs, an input differential amplifier provides these required inputs. The output voltage then depends upon the difference (or error) between the two input voltages. An input common-mode voltage range specification exists and, basically, input voltages are compared.

For circuit simplicity, and ease of application in single power supply systems, a non-inverting input can be provided by adding a standard IC "current-mirror" circuit directly across the inverting input terminal, as shown in *Figure 3*.



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FIGURE 3. Adding a Current Mirror to Achieve a Non-inverting Input

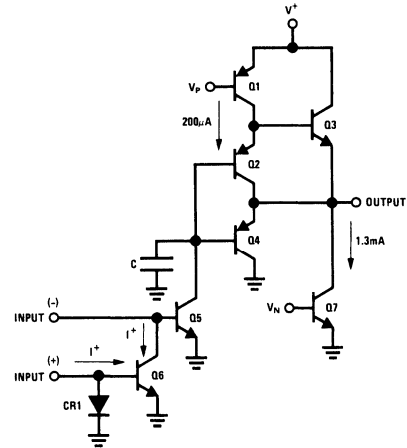
This operates in the current mode as now input currents are compared or differenced (this can be thought of as a Norton differential amplifier). There is essentially no input common-mode voltage range directly at the input terminals (as both inputs will bias at one diode drop above ground) but if the input voltages are converted to currents (by use of input resistors), there is then no limit to the common-mode input voltage range. This is especially useful in high-voltage comparator applications. By making use of the input resistors, to convert input voltages to input currents, all of the standard op amp applications can be realized. Many additional applications are easily achieved, especially when operating with only a single power supply voltage. This results from the built-in voltage biasing that exists at both inputs (each input biases at $+V_{BE}$) and additional resistors are not required to

provide a suitable common-mode input DC biasing voltage level. Further, input summing can be performed at the relatively low impedance level of the input diode of the current-mirror circuit.

1.3 THE COMPLETE SINGLE-SUPPLY AMPLIFIER

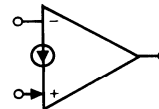
The circuit schematic for a single amplifier stage is shown in *Figure 4a*. Due to the circuit simplicity, four of these amplifiers can be fabricated on a single chip. One common biasing circuit is used for all of the individual amplifiers.

A new symbol for this "Norton" amplifier is shown in *Figure 4b*. This is recommended to avoid using the standard op amp symbol as the basic operation is different. The current source symbol between the inputs implies this new current-mode of operation. In addition, it signifies that current is



TL/H/7383-4

(a) Circuit Schematic



TL/H/7383-5

(b) New "NORTON" Amplifier Symbol

FIGURE 4. The Amplifier Stage

removed from the (-) input terminal. Also, the current arrow on the (+) input lead is used to indicate that this functions as a current input. The use of this symbol is helpful in understanding the operation of the application circuits and also in doing additional design work with the LM3900.

The bias reference for the PNP current source, V_p which biases Q_1 , is designed to cause the upper current source (200 μ A) to change with temperature to give first order compensation for the β variations of the NPN output transistor, Q_3 . The bias reference for the NPN "pull-down" current sink, V_n , (which biases Q_7) is designed to stabilize this current (1.3 mA) to reduce the variation when the temperature is changed. This provides a more constant pull-down capability for the amplifier over the temperature range. The transistor, Q_4 , provides the class B action which exists under large signal operating conditions.

The performance characteristics of each amplifier stage are summarized below:

Power-supply voltage range 4 to 36 V_{DC} or ± 2 to $\pm 18 V_{DC}$

Bias current drain per amplifier stage 1.3 mA $_{DC}$

Open loop:

Voltage gain ($R_L = 10k$) 70 dB

Unity-gain frequency 2.5 MHz

Phase margin 40°

Input resistance 1 M Ω

Output resistance 8 k Ω

Output voltage swing $(V_{CC} - 1) V_{pp}$

Input bias current 30 nA $_{DC}$

Slew rate 0.5V/ μ s

As the bias currents are all derived from diode forward voltage drops, there is only a small change in bias current magnitude as the power-supply voltage is varied. The open-loop gain changes only slightly over the complete power supply voltage range and is essentially independent of temperature changes. The open-loop frequency response is compared with the "741" op amp in Figure 5. The higher unity-gain crossover frequency is seen to provide an additional 10 dB of gain for all frequencies greater than 1 kHz.

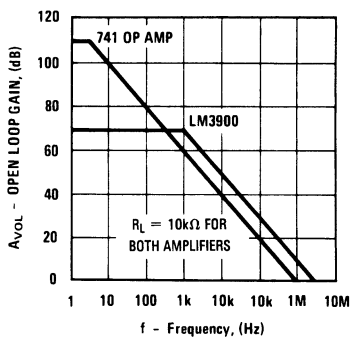


FIGURE 5. Open-loop Gain Characteristics

The complete schematic diagram of the LM3900 is shown in Figure 6. The one resistor, R_5 , establishes the power consumption of the circuit as it controls the conduction of transistor Q_{28} . The emitter current of Q_{28} is used to bias the NPN output class-A biasing current sources and the collector current of Q_{28} is the reference for the PNP current source of each amplifier.

The biasing circuit is initially "started" by Q_{20} , Q_{30} and CR_6 . After start-up is achieved, Q_{30} goes OFF and the current flow through the reference diodes: CR_5 , CR_7 and CR_8 , is dependent only on $V_{BE}/(R_6 + R_7)$. This guarantees that the power supply current drain is essentially independent of the magnitude of the power supply voltage.

The input clamp for negative voltages is provided by the multi-emitter NPN transistor Q_{21} . One of the emitters of this transistor goes to each of the input terminals. The reference voltage for the base of Q_{21} is provided by R_6 and R_7 and is approximately $V_{BE}/2$.

2.0 Introduction to Applications of the LM3900

Like the standard IC op amp, the LM3900 has a wide range of applications. A new approach must be taken to design circuits with this "Norton" amplifier and the object of this note is to present a variety of useful circuits to indicate how conventional and unique new applications can be designed—especially when operating with only a single power supply voltage.

To understand the operation of the LM3900 we will compare it with the more familiar standard IC op amp. When operating on a single power supply voltage, the minimum input common-mode voltage range of a standard op amp limits the smallest value of voltage which can be applied to both inputs and still have the amplifier respond to a differential input signal. In addition, the output voltage will not swing completely from ground to the power supply voltage. The output voltage depends upon the difference between the input voltages and a bias current must be supplied to both inputs. A simplified diagram of a standard IC op amp operating from a single power supply is shown in Figure 7. The (+) and (-) inputs go only to current sources and therefore are free to be biased or operated at any voltage values which are within the input common-mode voltage range. The current sources at the input terminals, I_B^+ and I_B^- , represent the bias currents which must be supplied to both of the input transistors of the op amp (base currents). The output circuit is modeled as an active voltage source which depends upon the open-loop gain of the amplifier, A_v , and the difference which exists between the input voltages, $(V^+ - V^-)$.

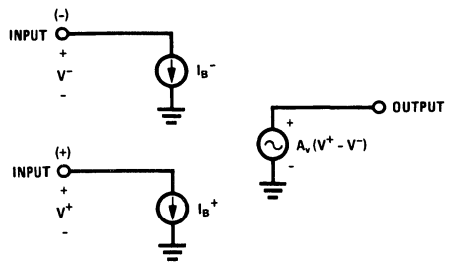


FIGURE 7. An Equivalent Circuit of a Standard IC Op Amp

An equivalent circuit for the "Norton" amplifier is shown in Figure 8. The (+) and (-) inputs are both clamped by diodes to force them to be one-diode drop above ground—always! They are not free to move and the "input common-mode voltage range" directly at these input terminals is very small—a few hundred mV centered about 0.5 V_{DC} . This is

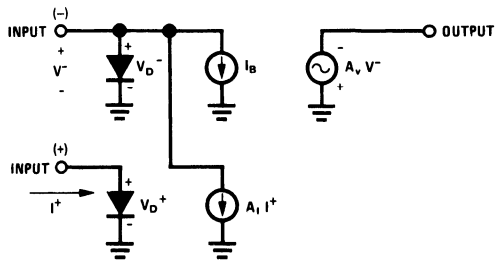
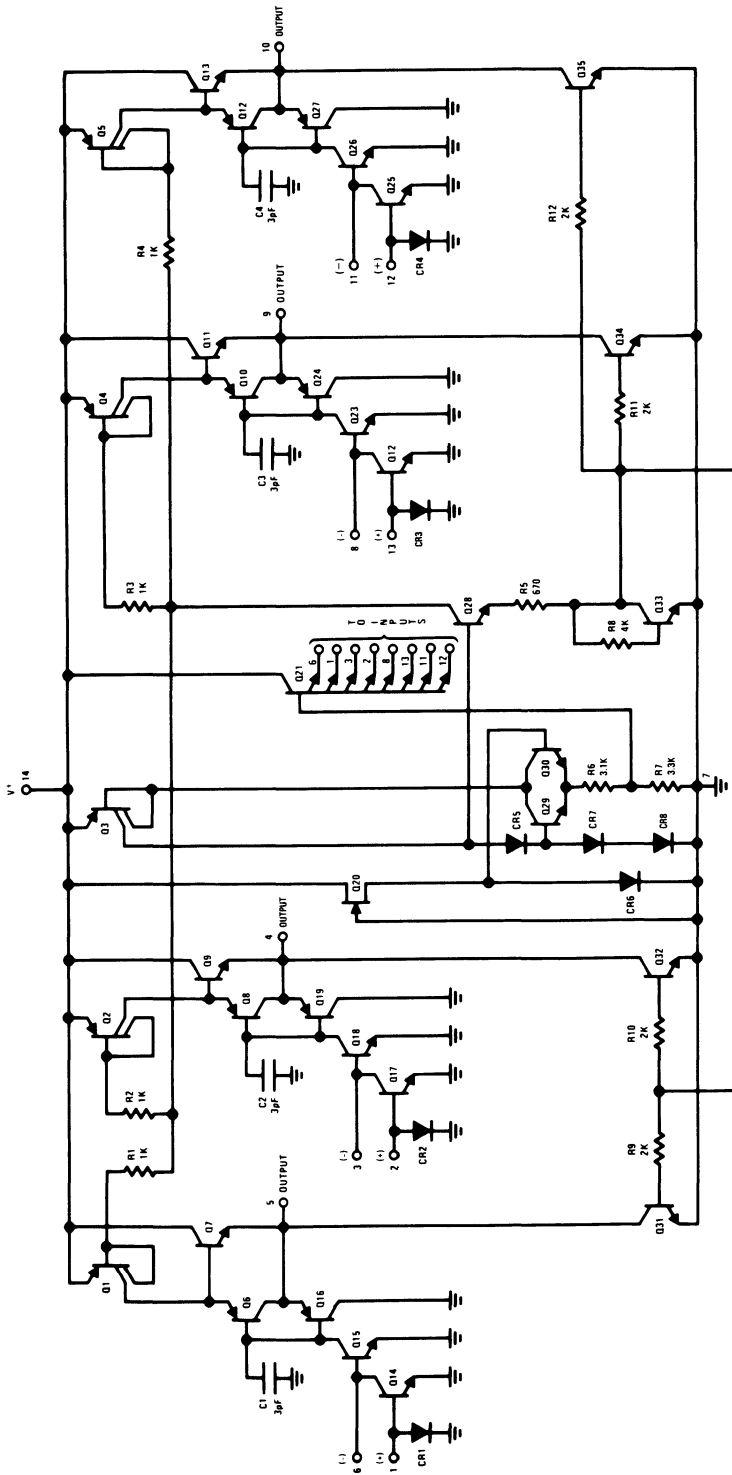


FIGURE 8. An Equivalent Circuit of the "Norton" Amplifier



TL/H7383-7

FIGURE 6. Schematic Diagram of the LM3900

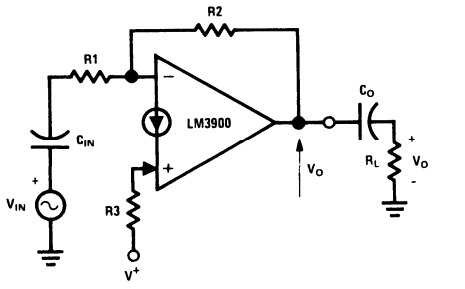
why external voltages must be first converted to currents (using resistors) before being applied to the inputs—and is the basis for the current-mode (or Norton) type of operation. With external input resistors—there is *no limit* to the “input common-mode voltage range”. The diode shown across the (+) input actually exists as a diode in the circuit and the diode across the (-) input is used to model the base-emitter junction of the transistor which exists at this input.

Only the (-) input must be supplied with a DC biasing current, I_B . The (+) input couples only to the (-) input and then to extract from this (-) input terminal the same current (A_1 , the mirror gain, is approximately equal to 1) which is entered (by the external circuitry) into the (+) input terminal. This operation is described as a “current-mirror” as the current entering the (+) input is “mirrored” or “reflected” about ground and is then extracted from the (-) input. There is a maximum or near saturation value of current which the “mirror” at the (+) input can handle. This is listed on the data sheet as “maximum mirror current” and ranges from approximately 6 mA at 25°C to 3.8 mA at 70°C.

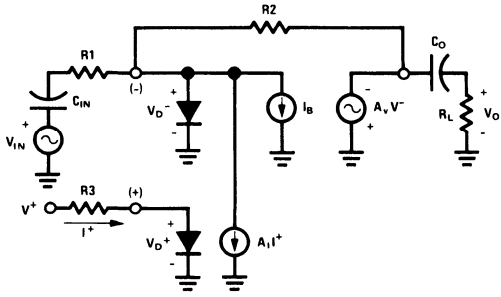
This fact that the (+) input current modulates or affects the (-) input current causes this amplifier to pass currents between the input terminals and is the basis for many new application circuits—especially when operating with only a single power supply voltage.

The output is modeled as an active voltage source which also depends upon the open-loop voltage gain, A_v , but only the (-) input voltage, V^- , (not the differential input voltage). Finally, the output voltage of the LM3900 can swing from essentially ground (+90 mV) to within one V_{BE} of the power supply voltage.

As an example of the use of the equivalent circuit of the LM3900, the AC coupled inverting amplifier of Figure 9a will



(a) A Typical Biased Amplifier TL/H/7383-10



(b) Using the LM3900 Equivalent Circuit TL/H/7383-11

FIGURE 9. Applying the LM3900 Equivalent Circuit

be analyzed. Figure 9b shows the complete equivalent circuit which, for convenience, can be separated into a biasing equivalent circuit (Figure 10) and an AC equivalent circuit (Figure 11). From the biasing model of Figure 10 we find the output quiescent voltage, V_O , is:

$$V_O = V_{D^-} + (I_B + I^+) R_2, \tag{1}$$

and

$$I^+ = \frac{V^+ - V_{D^+}}{R_3} \tag{2}$$

where

$$V_{D^+} \cong V_{D^-} \cong 0.5 V_{DC}$$

$$I_B = \text{INPUT bias current (30 nA)}$$

and

$$V^+ = \text{Power supply voltage.}$$

If (2) is substituted into (1)

$$V_O = V_{D^-} + \left(I_B + \frac{V^+ - V_{D^+}}{R_3} \right) R_2 \tag{3}$$

which is an exact expression for V_O .

As the second term usually dominates ($V_O \gg V_{D^-}$) and $I^+ \gg I_B$ and $V^+ \gg V_{D^+}$ we can simplify (3) to provide a more useful design relationship

$$V_O \cong \frac{R_2}{R_3} V^+. \tag{4}$$

Using (4), if $R_3 = 2R_2$ we find

$$V_O \cong \frac{R_2}{2R_2} V^+ = \frac{V^+}{2}, \tag{5}$$

which shows that the output is easily biased to one-half of the power supply voltage by using V^+ as a biasing reference at the (+) input.

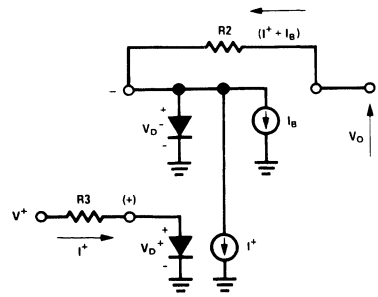


FIGURE 10. Biasing Equivalent Circuit TL/H/7383-12

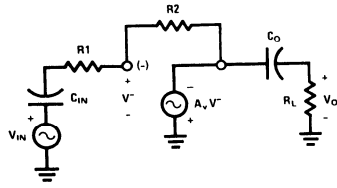


FIGURE 11. AC Equivalent Circuit TL/H/7383-13

The AC equivalent circuit of *Figure 11* is the same as that which would result if a standard IC op amp were used with the (+) input grounded. The closed-loop voltage gain A_{VCL} is given by:

$$A_{VCL} \equiv \frac{V_O}{V_{IN}} \equiv -\frac{R_2}{R_1} \quad (6)$$

if A_v (open-loop) $> \frac{R_2}{R_1}$.

The design procedure for an AC coupled inverting amplifier using the LM3900 is therefore to first select R_1 , C_{IN} , R_2 , and C_O as with a standard IC op amp and then to simply add $R_3 = 2R_2$ as a final biasing consideration. Other biasing techniques are presented in the following sections of this note. For the switching circuit applications, the biasing model of *Figure 10* is adequate to predict circuit operation.

Although the LM3900 has four independent amplifiers, the use of the label "1/4LM3900" will be shortened to simply "LM3900" for the application drawings contained in this note.

3.0 Designing AC Amplifiers

The LM3900 readily lends itself to use as an AC amplifier because the output can be biased to any desired DC level within the range of the output voltage swing and the AC gain is independent of the biasing network. In addition, the single power supply requirement makes the LM3900 attractive for any low frequency gain application. For lowest noise performance, the (+) input should be grounded (*Figure 9a*) and the output will then bias at $+V_{BE}$. Although the LM3900 is not suitable as an ultra low noise tape pre-amp, it is useful in most other applications. The restriction to only shunt feedback causes a small input impedance. Transducers which can be loaded can operate with this low input impedance. The noise degradation which would result from the use of a large input resistor limits the usefulness where low noise and high input impedance are both required.

3.1 SINGLE POWER SUPPLY BIASING

The LM3900 can be biased in several different ways. The circuit in *Figure 12* is a standard inverting AC amplifier which has been biased from the same power supply which is used to operate the amplifier. (The design of this amplifier has been presented in the previous section.) Notice that if AC ripple voltages are present on the V^+ power supply line they will couple to the output with a "gain" of $1/2$. To eliminate this, one source of ripple filtered voltage can be provided and then used for many amplifiers. This is shown in the next section.

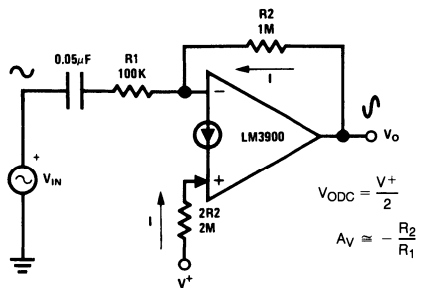


FIGURE 12. Inverting AC Amplifier Using Single-Supply Biasing

TL/H/7383-14

3.2 A NON-INVERTING AMPLIFIER

The amplifier in *Figure 13* shows both a non-inverting AC amplifier and a second method for DC biasing. Once again the AC gain of the amplifier is set by the ratio of feedback resistor to input resistor. The small signal impedance of the diode at the (+) input should be added to the value of R_1 when calculating gain, as shown in *Figure 13*.

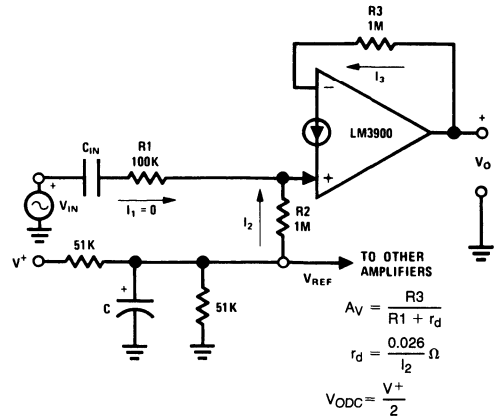


FIGURE 13. Non-inverting AC Amplifier Using Voltage Reference Biasing

By making $R_2 = R_3$, V_{ODC} will be equal to the reference voltage which is applied to the resistor R_2 . The filtered $V^+ / 2$ reference shown can also be used for other amplifiers.

3.3 "N V_{BE} " BIASING

A third technique of output DC biasing is best described as the "N V_{BE} " method. This technique is shown in *Figure 14* and is most useful with inverting AC amplifier applications.

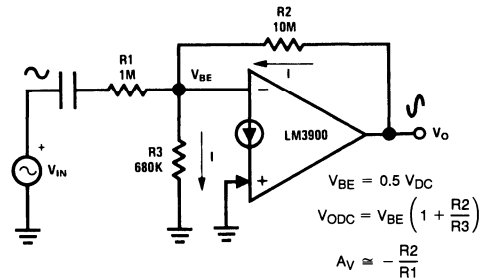


FIGURE 14. Inverting AC Amplifier Using N V_{BE} Biasing

The input bias voltage (V_{BE}) at the inverting input establishes a current through resistor R_3 to ground. This current must come from the output of the amplifier. Therefore, V_O must rise to a level which will cause this current to flow through R_2 . The bias voltage, V_O , may be calculated from the ratio of R_2 to R_3 as follows:

$$V_{ODC} = V_{BE} \left(1 + \frac{R_2}{R_3} \right)$$

When NV_{BE} biasing is employed, values for resistors R_1 and R_2 are first established and then resistor R_3 is added to provide the desired DC output voltage.

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For a design example (Figure 14), a $Z_{in} = 1M$ and $A_v \approx 10$ are required.

Select $R_1 = 1M$.

Calculate $R_2 \approx A_v R_1 = 10M$.

To bias the output voltage at $7.5 V_{DC}$, R_3 is found as:

$$R_3 = \frac{R_2}{\frac{V_O}{V_{BE}} - 1} = \frac{10M}{\frac{7.5}{0.5} - 1}$$

or

$$R_3 \approx 680 k\Omega.$$

3.4 BIASING USING A NEGATIVE SUPPLY

If a negative power supply is available, the circuit of Figure 15 can be used. The DC biasing current, I_1 , is established by the negative supply voltage via R_3 and provides a very stable output quiescent point for the amplifier.

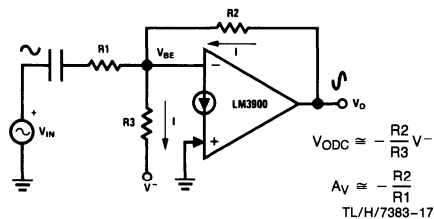


FIGURE 15. Negative Supply Biasing

3.5 OBTAINING HIGH INPUT IMPEDANCE AND HIGH GAIN

For the AC amplifiers which have been presented, a designer is able to obtain either high gain or high input impedance with very little difficulty. The application which requires both and still employs only one amplifier presents a new problem. This can be achieved by the use of a circuit similar to the one shown in Figure 16. When the A_v from the input to

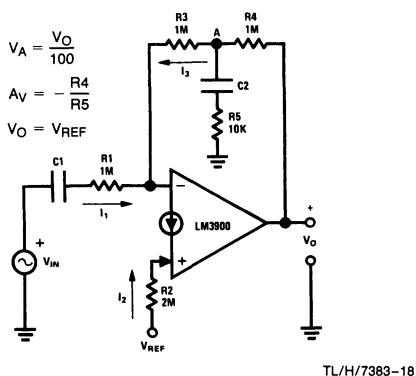


FIGURE 16. A High Z_{in} High Gain Inverting AC Amplifier

point A is unity ($R_1 = R_3$), the A_v of the complete stage will be set by the voltage divider network composed of R_4 , R_5 , and C_2 . As the value of R_5 is decreased, the A_v of the stage will approach the AC open loop limit of the amplifier. The insertion of capacitor C_2 allows the DC bias to be controlled by the series combination of R_3 and R_4 with no effect from R_5 . Therefore, R_2 may be selected to obtain the desired output DC biasing level using any of the methods which have been discussed. The circuit in Figure 16 has an input impedance of $1M$ and a gain of 100.

3.6 AN AMPLIFIER WITH A DC GAIN CONTROL

A DC gain control can be added to an amplifier as shown in Figure 17. The output of the amplifier is kept from being driven to saturation as the DC gain control is varied by providing a minimum biasing current via R_3 . For maximum gain, CR_2 is OFF and both the current through R_2 and R_3 enter the (+) input and cause the output of the amplifier to bias at approximately $0.6 V^+$. For minimum gain, CR_2 is ON and only the current through R_3 enters the (+) input to bias the output at approximately $0.3 V^+$. The proper output bias for large output signal accommodation is provided for the maximum gain situation. The DC gain control input ranges from $0 V_{DC}$ for minimum gain to less than $10 V_{DC}$ for maximum gain.

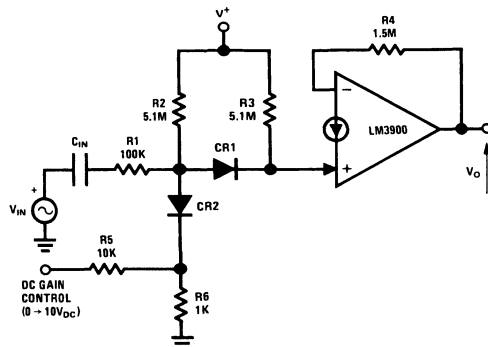


FIGURE 17. An Amplifier with a DC Gain Control

3.7 A LINE-RECEIVER AMPLIFIER

The line-receiver amplifier is shown in Figure 18. The use of both inputs cancels out common-mode signals. The line is terminated by R_{LINE} and the larger input impedance of the amplifier will not affect this matched loading.

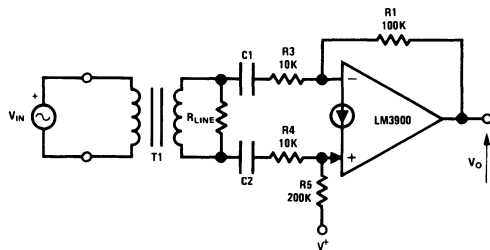


FIGURE 18. A Line-receiver Amplifier

4.0 Designing DC Amplifiers

The design of DC amplifiers using the LM3900 tends to be more difficult than the design of AC amplifiers. These difficulties occur when designing a DC amplifier which will operate from only a single power supply voltage and yet provide an output voltage which goes to zero volts DC and also will accept input voltages of zero volts DC. To accomplish this, the inputs must be biased into the linear region ($+V_{BE}$) with DC input signals of zero volts and the output must be modified if operation to actual ground (and not V_{SAT}) is required. Therefore, the problem becomes one of determining what type of network is necessary to provide an output voltage (V_O) equal to zero when the input voltage (V_{IN}) is equal to zero. (See also section 10.15, "adding a Differential Input Stage").

We will start with a careful evaluation of what actually takes place at the amplifier inputs. The mirror circuit demands that the current flowing into the positive input (+) be equaled by a current flowing into the negative input (-). The difference between the current demanded and the current provided by an external source must flow in the feedback circuit. The output voltage is then forced to seek the level required to cause this amount of current to flow. If, in the steady state condition $V_O = V_{IN} = 0$, the amplifier will operate in the desired manner. This condition can be established by the use of common-mode biasing at the inputs.

4.1 USING COMMON-MODE BIASING FOR $V_{IN} = 0 V_{DC}$

Common-mode biasing is achieved by placing equal resistors between the amplifier input terminals and the supply voltage (V^+), as shown in Figure 19. When V_{IN} is set to 0 volts the circuit can be modeled as shown in Figure 20,

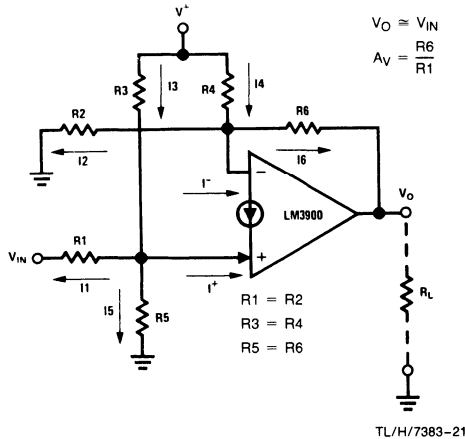


FIGURE 19. A DC Amplifier Employing Common-mode Biasing

where:

$$R_{EQ1} = R1 \parallel R5,$$

$$R_{EQ2} = R2 \parallel R6,$$

and

$$R3 = R4.$$

Because the current mirror demands that the two current sources be equal, the current in the two equivalent resistors must be identical.

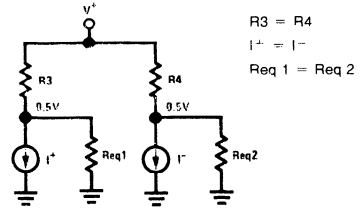


FIGURE 20. An Ideal Circuit Model of a DC Amplifier with Zero Input Voltage

If this is true, both R_2 and R_6 must have a voltage drop of 0.5 volt across them, which forces V_O to go to $V_O \text{ MIN}$ (V_{SAT}).

4.2 ADDING AN OUTPUT DIODE FOR $V_O = 0 V_{DC}$

For many applications a $V_O \text{ MIN}$ Of 100 mV may not be acceptable. To overcome this problem a diode can be added between the output of the amplifier and the output terminal (Figure 21).

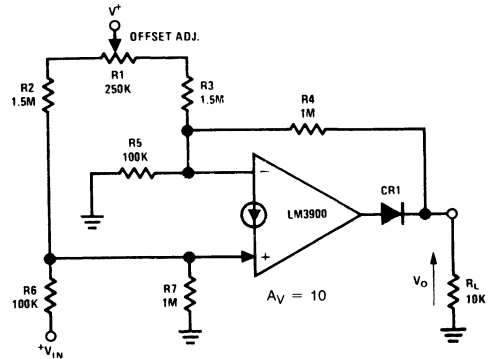


FIGURE 21. A Non-inverting DC Amplifier with Zero Volts Output for Zero Volts Input

The function of the diode is to provide a DC level shift which will allow V_O to go to ground. With a load impedance (R_L) connected, V_O becomes a function of the voltage divider formed by the series connection of R_4 and R_L .

$$\text{If } R_4 = 100 R_L, \text{ then } V_O \text{ MIN} = \frac{0.5 R_L}{101 R_L},$$

$$\text{or } V_O \text{ MIN} \approx 5 \text{ mV}_{DC}.$$

An offset voltage adjustment can be added as shown (R_1) to adjust V_O to $0V_{DC}$ with $V_{IN} = 0 V_{DC}$.

The voltage transfer functions for the circuit in Figure 21, both with and without the diode, are shown in Figure 22. While the diode greatly improves the operation around 0 volts, the voltage drop across the diode will reduce the peak output voltage swing of the state by approximately 0.5 volt. When using a DC amplifier similar to the one in Figure 21, the load impedance should be large enough to avoid excessively loading the amplifier. The value of R_L may be significantly reduced by replacing the diode with an NPN transistor.

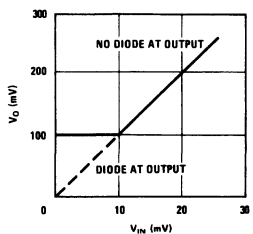


FIGURE 22. Voltage Transfer Function for a DC Amplifier with a Voltage Gain of 10

TL/H/7383-24

4.3 A DC COUPLED POWER AMPLIFIER (IL ≤ 3 AMPS)

The LM3900 can be used as a power amplifier by the addition of a Darlington pair at the output. The circuit shown in Figure 23 can deliver in excess of 3 amps to the load when the transistors are properly mounted on heat sinks.

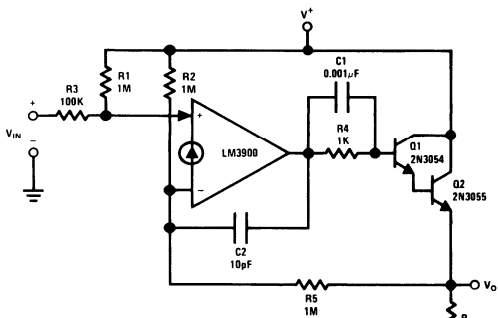


FIGURE 23. A DC Power Amplifier

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4.4 GROUND REFERENCING A DIFFERENTIAL VOLTAGE

The circuit in Figure 24 employs the LM3900 to ground reference a DC differential input voltage. Current I1 is larger

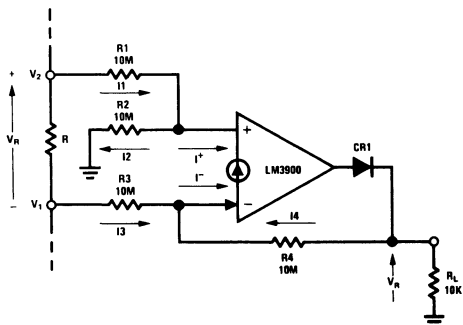


FIGURE 24. Ground Referencing a Differential Input DC Voltage

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than current I3 by a factor proportional to the differential voltage, VR. The currents labeled on Figure 24 are given by:

$$I_1 = \frac{V_1 + V_R - \phi}{R_1}$$

$$I_2 = \phi / R_2$$

$$I_3 = \frac{(V_1 - \phi)}{R_3}$$

$$I_4 = \frac{V_O - \phi}{R_4}$$

and

where

$\phi \equiv V_{BE}$ at either input terminal of the LM3900.

Since the input current mirror demands that

$$I^- = I^+;$$

and

$$I^+ = I_1 - I_2$$

and

$$I^- = I_3 + I_4$$

Therefore

$$I_4 = I_1 - I_2 - I_3.$$

Substituting in from the above equation

$$\frac{V_O - \phi}{R_4} = \frac{(V_1 + V_R - \phi)}{R_1} - \frac{(\phi)}{R_2} - \frac{(V_1 - \phi)}{R_3}$$

and as $R_1 = R_2 = R_3 = R_4$

$$V_O = (V_1 + V_R - \phi) - (\phi) - V_1 + \phi + \phi$$

or

$$V_O = V_R.$$

The resistors are kept large to minimize loading. With the 10 MΩ resistors which are shown on the figure, an error exists at small values of V1 due to the input bias current at the (-) input. For simplicity this has been neglected in the circuit description. Smaller R values reduce the percentage error or the bias current can be supplied by an additional amplifier (see Section 10.7.1).

For proper operation, the differential input voltage must be limited to be within the output dynamic voltage range of the amplifier and the input voltage V2 must be greater than 1 volt. For example; if V2 = 1 volt, the input voltage V1 may vary over the range of 1 volt to -13 volts when operating from a 15 volt supply. Common-mode biasing may be added as shown in Figure 25 to allow both V1 and V2 to be negative.

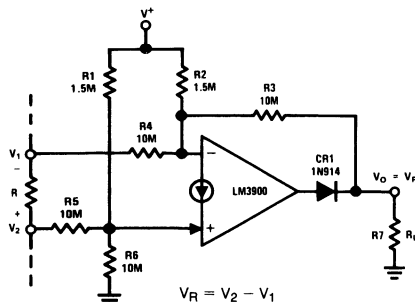


FIGURE 25. A Network to Invert and to Ground Reference a Negative DC Differential Input Voltage

TL/H/7383-27

4.5 A UNITY GAIN BUFFER AMPLIFIER

The buffer amplifier with a gain of one is the simplest DC application for the LM3900. The voltage applied to the input (Figure 26) will be reproduced at the output. However, the input voltage must be greater than one VBE but less than the maximum output swing. Common-mode biasing can be added to extend VIN to 0 VDC, if desired.

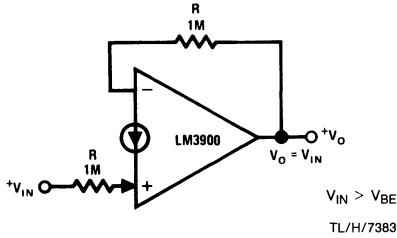


FIGURE 26. A Unity-gain DC Buffer Amplifier

5.0 Designing Voltage Regulators

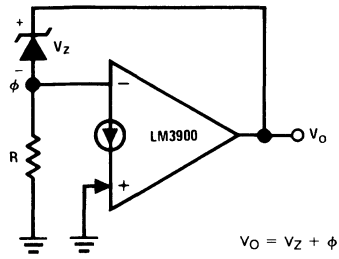
Many voltage regulators can be designed which make use of the basic amplifier of the LM3900. The simplest is shown in Figure 27a where only a Zener diode and a resistor are added. The voltage at the (-) input (one $V_{BE} \approx 0.5 V_{DC}$) appears across R and therefore a resistor value of 510Ω will cause approximately 1 mA of bias current to be drawn through the Zener. This biasing is used to reduce the noise output of the Zener as the 30 nA input current is too small for proper Zener biasing. To compensate for a positive temperature coefficient of the Zener, an additional resistor can be added, R_2 , (Figure 27b) to introduce an arbitrary number, N, of "effective" V_{BE} drops into the expression for the output voltage. The negative temperature coefficient of these diodes will also be added to temperature compensate the DC output voltage. For a larger output current, an emitter follower (Q_1 of Figure 27c) can be added. This will multiply the 10 mA (max.) output current of the LM3900 by the β of the added transistor. For example, a $\beta = 30$ will provide a max. load current of 300 mA. This added transistor also reduces the output impedance. An output frequency compensation capacitor is generally not required but may be added, if desired, to reduce the output impedance at high frequencies.

The DC output voltage can be increased and still preserve the temperature compensation of Figure 27b by adding resistors R_A and R_B as shown in Figure 27d. This also can be accomplished without the added transistor, Q_1 . The unregulated input voltage, which is applied to pin 14 of the LM3900 (and to the collector of Q_1 , if used) must always exceed the regulated DC output voltage by approximately 1V, when the unit is not current boosted or approximately 2V when the NPN current boosting transistor is added.

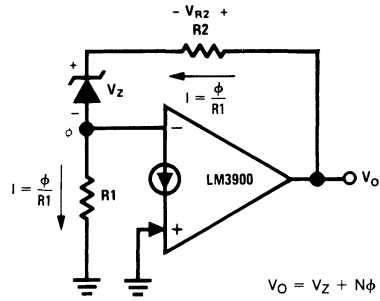
5.1 REDUCING THE INPUT-OUTPUT VOLTAGE

The use of an external PNP transistor will reduce the required $(V_{IN} - V_{OUT})$ to a few tenths of a volt. This will depend on the saturation characteristics of the external transistor at the operating current level. The circuit, shown in Figure 28, uses the LM3900 to supply base drive to the PNP transistor. The resistors R_1 and R_2 are used to allow the output of the amplifier to turn OFF the PNP transistor. It is important that pin 14 of the LM3900 be tied to the $+V_{IN}$ line to allow this OFF control to properly operate. Larger voltages are permissible (if the base-emitter junction of Q_1 is prevented from entering a breakdown by a shunting diode, for example), but smaller voltages will not allow the output of the amplifier to raise enough to give the OFF control.

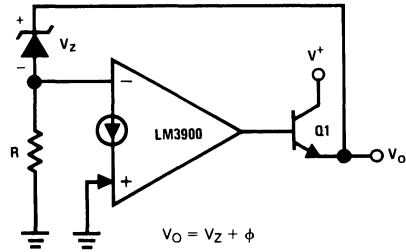
The resistor, R_3 , is used to supply the required bias current for the amplifier and R_4 is again used to bias the Zener diode. Due to a larger gain, a compensation capacitor, C_O , is required. Temperature compensation could be added as was shown in Figure 27b.



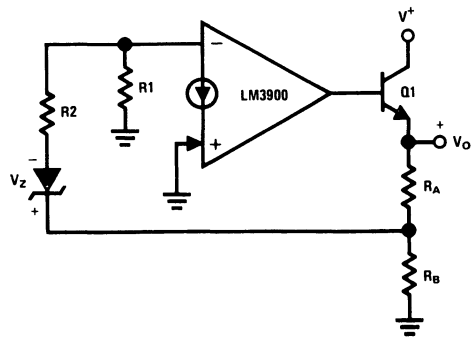
(a) Basic Current



(b) Temperature Compensating

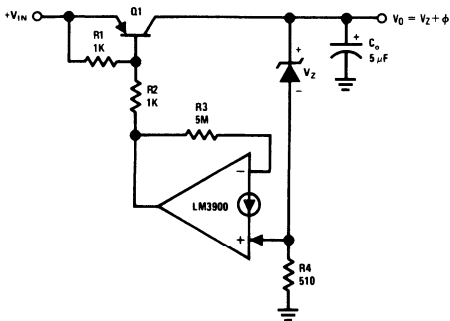


(c) Current Boosting



(d) Raising V_O Without Disturbing Temperature Compensation

FIGURE 27. Simple Voltage Regulators

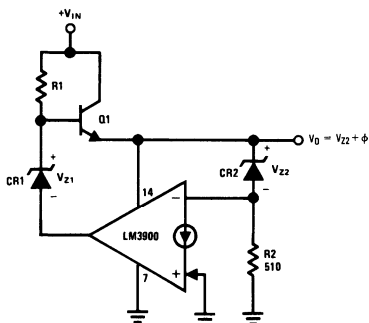


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FIGURE 28. Reducing $(V_{IN} - V_{OUT})$

5.2 PROVIDING HIGH INPUT VOLTAGE PROTECTION

One of the four amplifiers can be used to regulate the supply line for the complete package (pin 14), to provide protection against large input voltage conditions, and in addition, to supply current to an external load. This circuit is shown in Figure 29. The regulated output voltage is the sum of the Zener voltage, CR_2 , and the V_{BE} of the inverting input terminal. Again, temperature compensation can be added as in Figure 27b. The second Zener, CR_1 , is a low tolerance component which simply serves as a DC level shift to allow the output voltage of the amplifier to control the conduction of the external transistor, Q_1 . This Zener voltage should be approximately one-half of the CR_2 voltage to position the DC Output voltage level of the amplifier approximately in the center of the dynamic range.



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FIGURE 29. High V_{IN} Protection and Self-regulation

The base drive current for Q_1 is supplied via R_1 . The maximum current through R_1 should be limited to 10 mA as

$$I_{MAX} = \frac{V_{IN(MAX)} - (V_O + V_{BE})}{R_1}$$

To increase the maximum allowed input voltage, reduce the output ripple, or to reduce the $(V_{IN} - V_{OUT})$ requirements of this circuit, the connection described in the next section is recommended.

5.3 HIGH INPUT VOLTAGE PROTECTION AND LOW $(V_{IN} - V_{OUT})$

The circuit shown in Figure 30 basically adds one additional transistor to the circuit of Figure 29 to improve the performance. In this circuit both transistors (Q_1 and Q_2) absorb any high input voltages (and therefore need to be high voltage devices) without any increases in current (as with R_1 of Figure 29). The resistor R_1 (of Figure 30) provides a "start-up" current into the base of Q_2 .

A new input connection is shown on this regulator (the type on Figure 29 could also be used) to control the DC output voltage. The Zener is biased via R_4 (at approximately 1 mA). The resistors R_3 and R_6 provide gain (non-inverting) to allow establishing V_O at any desired voltage larger than V_Z . Temperature compensation of either sign ($\pm TC$) can be obtained by shunting a resistor from either the (+) input to ground (to add $+ TC$ to V_O) or from the (-) input to ground (to add $- TC$ to V_O). To understand this, notice that the resistor, R , from the (+) input to ground will add $-N V_{BE}$ to V_O where

$$N = 1 + \frac{R_3}{R_1}$$

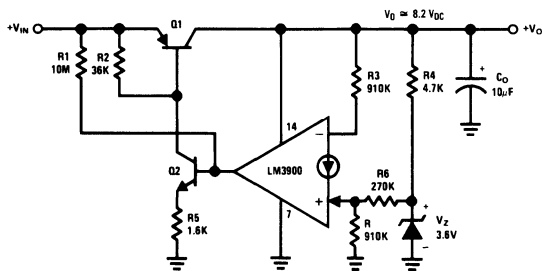
and V_{BE} is the base emitter voltage of the transistor at the (+) input. This then also adds a positive temperature change at the output to provide the desired temperature correction.

The added transistor, Q_2 , also increases the gain (which reduces the output impedance) and if a power device is used for Q_1 large load currents (amps) can be supplied. This regulator also supplies the power to the other three amplifiers of the LM3900.

5.4 REDUCING INPUT VOLTAGE DEPENDENCE AND ADDING SHORT-CIRCUIT PROTECTION

To reduce ripple feedthrough and input voltage dependence, diodes can be added as shown in Figure 31 to drop-out the start once start-up has been achieved. Short-circuit protection can also be added as shown in Figure 32.

The emitter resistor of Q_2 will limit the maximum current of Q_2 to $(V_O - 2 V_{BE})/R_5$.



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FIGURE 30. A High V_{IN} Protected, Low $(V_{IN} - V_{OUT})$ Regulator

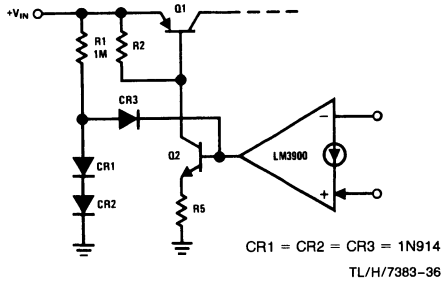
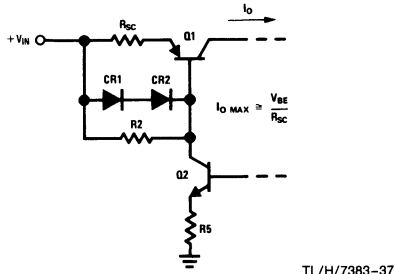
FIGURE 31. Reducing V_{IN} Dependence

FIGURE 32. Adding Short-circuit Current Limiting

6.0 Designing RC Active Filters

Recent work in RC active filters has shown that the performance characteristics of multiple-amplifier filters are relatively insensitive to the tolerance of the RC components used. This makes the performance of these filters easier to control in production runs. In many cases where gain is needed in a system design it is now relatively easy to also get frequency selectivity.

The basis of active filters is a gain stage and therefore a multiple amplifier product is a valuable addition to this application area. When additional amplifiers are available, less component selection and trimming is needed as the performance of the filter is less disturbed by the tolerance and temperature drifts of the passive components.

The *passive components do control the performance of the filter* and for this reason carbon composition resistors are useful mainly for room temperature breadboarding or for final trimming of the more stable metal film or wire-wound resistors. Capacitors present more of a problem in range of values available, tolerance and stability (with temperature, frequency, voltage and time). For example, the disk ceramic type of capacitors are generally not suited to active filter applications due to their relatively poor performance.

The impedance level of the passive components can be scaled without (theoretically) affecting the filter characteristics. In an actual circuit; if the resistor values become too small ($\leq 10 \text{ k}\Omega$) an excessive loading may be placed on the output of the amplifier which will reduce gain or actually exceed either the output current or the package dissipation capabilities of the amplifier. This can easily be checked by calculating (or noticing) the impedance which is presented to the output terminal of the amplifier at the highest operating frequency. A second limit sets the upper range of impedance levels, this is due to the DC bias currents ($\approx 30 \text{ nA}$) and the input impedance of actual amplifiers. The solution to this problem is to reduce the impedance levels of the passive components ($\leq 10 \text{ M}\Omega$). In general, better perform-

ance is obtained with relatively low passive component impedance levels and in filters which do not demand high gain, high Q ($Q \geq 50$) and high frequency ($f_0 > 1 \text{ kHz}$) simultaneously.

A measure of the effects of changes in the values of the passive components on the filter performance has been given by "sensitivity functions". These assume infinite amplifier gain and relate the percentage change in a parameter of the filter, such as center frequency (f_0), Q, or gain to a percentage change in a particular passive component. Sensitivity functions which are small are desirable (as 1 or $1/2$).

Negative signs simply mean an increase in the value of a passive component causes a decrease in that filter performance characteristic. As an example, if a bandpass filter listed the following sensitivity factor

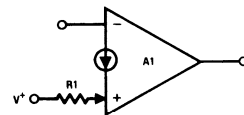
$$S_{\omega_0} = -\frac{1}{2} \cdot \frac{1}{C_3}$$

This states that "if C_3 were to increase by 1%, the center frequency, ω_0 , would decrease by 0.5%." Sensitivity functions are tabulated in the reference listed at the end of this section and will therefore not be included here.

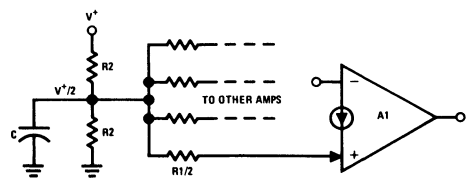
A brief look at low pass, high pass and bandpass filters will indicate how the LM3900 can be applied in these areas. A recommended text (which provided these circuits) is, "Operational Amplifiers", Tobey, Graeme, and Huelsman, McGraw Hill, 1971.

6.1 BIASING THE AMPLIFIERS

Active filters can be easily operated off of a single power supply when using these multiple single supply amplifiers. The general technique is to use the (+) input to accomplish the biasing function. The power supply voltage, V^+ , is used as the DC reference to bias the output voltage of each amplifier at approximately $V^+ / 2$. As shown in Figure 33, undesired AC components on the power supply line may have to



(a) Biasing From a "Noise-Free" Power Supply



(b) Biasing From a "Noisy" Power Supply

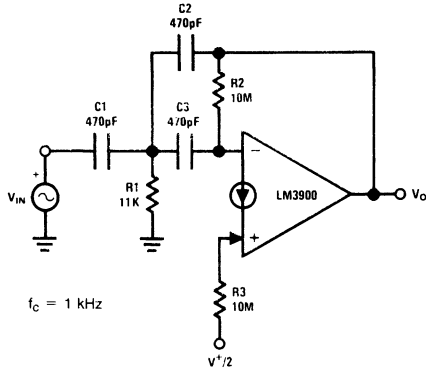
FIGURE 33. Biasing Considerations

be removed (by a filter capacitor, Figure 33b) to keep the filter output free of this noise. One filtered DC reference can generally be used for all of the amplifiers as there is essentially no signal feedback to this bias point.

In the filter circuits presented here, all amplifiers will be biased at $V^+ / 2$ to allow the maximum AC voltage swing for any given DC power supply voltage. The inputs to these filters will also be assumed at a DC level of $V^+ / 2$ (for those which are direct coupled).

6.2 A HIGH PASS ACTIVE FILTER

A single amplifier high pass RC active filter is shown in *Figure 34*. This circuit is easily biased using the (+) input of the LM3900. The resistor, R_3 , can be simply made equal to R_2 and a bias reference of $V^+/2$ will establish the output Q point at this value ($V^+/2$). The input is capacitively coupled (C_1) and there are therefore no further DC biasing problems.



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FIGURE 34. A High Pass Active Filter

The design procedure for this filter is to select the pass band gain, H_O , the Q and the corner frequency, f_c . A Q value of 1 gives only a slight peaking near the bandedge (<2 dB) and smaller Q values decrease this peaking. The slope of the skirt of this filter is 12 dB/octave (or 40 dB/decade). If the gain, H_O , is unity all capacitors have the same value. The design proceeds as:

Given: H_O , Q and $\omega_c = 2\pi f_c$

To find: R_1 , R_2 , C_1 , C_2 , and C_3

let $C_1 = C_3$ and choose a convenient starting value.

Then:

$$R_1 = \frac{1}{Q \omega_c C_1 (2H_O + 1)} \quad (1)$$

$$R_2 = \frac{Q}{\omega_c C_1} (2H_O + 1), \quad (2)$$

and

$$C_2 = \frac{C_1}{H_O} \quad (3)$$

As a design example,

Require: $H_O = 1$,

$Q = 10$,

and $f_c = 1 \text{ kHz}$ ($\omega_c = 6.28 \times 10^3 \text{ rps}$).

Start by selecting $C_1 = 300 \text{ pF}$ and then from equation (1)

$$R_1 = \frac{1}{(10)(6.28 \times 10^3)(3 \times 10^{-10})} \quad (3)$$

$$R_1 = 17.7 \text{ k}\Omega$$

and from equation (2)

$$R_2 = \frac{10}{(6.28 \times 10^3)(3 \times 10^{-10})} \quad (3)$$

$$R_2 = 15.9 \text{ M}\Omega$$

and from equation (3)

$$C_2 = \frac{C_1}{1} = C_1$$

Now we see that the value of R_2 is quite large; but the other components look acceptable. Here is where impedance scaling comes in. We can reduce R_2 to the more convenient value of $10 \text{ M}\Omega$ which is a factor of 1.59:1. Reducing R_1 by this same scaling factor gives:

$$R_{1\text{NEW}} = \frac{17.7 \times 10^3}{1.59} = 11.1 \text{ k}\Omega$$

and the capacitors are similarly reduced in impedance as:

$$(C_1 = C_2 = C_3)_{\text{NEW}} = (1.59)(300) \text{ pF}$$

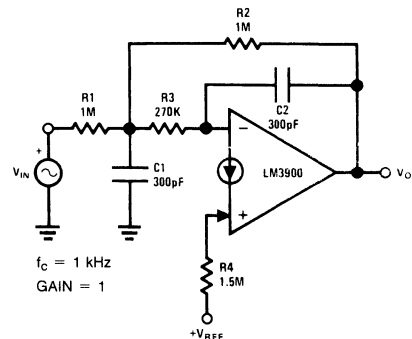
$$C_{1\text{NEW}} = 477 \text{ pF.}$$

To complete the design, R_3 is made equal to R_2 ($10 \text{ M}\Omega$) and a V_{REF} of $V^+/2$ is used to bias the output for large signal accommodation.

Capacitor values should be adjusted to use standard valued components by using impedance scaling as a wider range of standard resistor values is generally available.

6.3 A LOW PASS ACTIVE FILTER

A single amplifier low pass filter is shown in *Figure 35*. The resistor, R_4 , is used to set the output bias level and is selected after the other resistors have been established.



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FIGURE 35. A Low Pass Active Filter

The design procedure is as follows:

Given: H_O , Q , and $\omega_c = 2\pi f_c$

To find: R_1 , R_2 , R_3 , R_4 , C_1 , and C_2

Let C_1 be a convenient value,

then

$$C_2 = KC_1 \quad (4)$$

where K is a constant which can be used to adjust component values. For example, with $K = 1$, $C_1 = C_2$. Larger values of K can be used to reduce R_2 and R_3 at the expense of a larger value for C_2 .

$$R_1 = \frac{R_2}{H_O}, \quad (5)$$

$$R_2 = \frac{1}{2Q \omega_c C_1} \left[1 \pm \sqrt{1 + \frac{4Q^2 (H_O + 1)}{K}} \right] \quad (6)$$

and

$$R_3 = \frac{1}{\omega_c^2 C_1^2 R_2 (K)} \quad (7)$$

As a design example:

Require: $H_O = 1$,

$Q = 1$,

and $f_c = 1 \text{ kHz}$ ($\omega_c = 6.28 \times 10^3 \text{ rps}$).

Start by selecting $C_1 = 300 \text{ pF}$ and $K = 1$ so C_2 is also 300 pF (equation 4).

Now from equation (6)

$$R_2 = \frac{1}{2(1)(6.28 \times 10^3)(3 \times 10^{-10})} \left[1 \pm \sqrt{1 + 4(2)} \right]$$

$$R_2 = 1.06 \text{ M}\Omega$$

Then from equation (5)

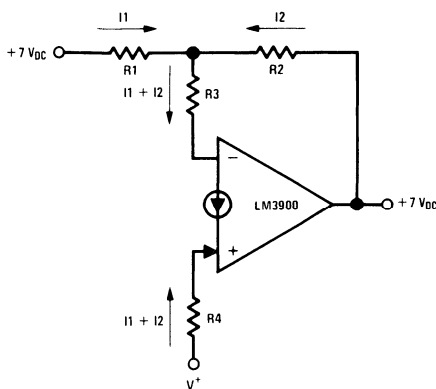
$$R_1 = R_2 = 1.06 \text{ M}\Omega$$

and finally from equation (7)

$$R_3 = \frac{1}{(6.28 \times 10^3)^2 (3 \times 10^{-10})^2 (1.06 \times 10^6) (1)}$$

$$R_3 = 266 \text{ k}\Omega.$$

To select R_4 , we assume the DC input level is 7 V_{DC} and the DC output of this filter is to also be 7 V_{DC} . This gives us the circuit of Figure 36. Notice that $H_0 = 1$ gives us not only



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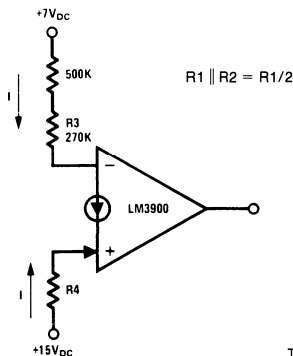
FIGURE 36. Biasing the Low Pass Filter

equal resistor values (R_1 and R_2) but simplifies the DC bias calculation as $I_1 = I_2$ and we have a DC amplifier with a gain of -1 (so if the DC input voltage increases 1 V_{DC} the output voltage decreases 1 V_{DC}). The resistors R_1 and R_2 are in parallel so that the circuit simplifies to that shown in Figure 37 where the actual resistance values have been added. The resistor R_4 is given by

$$R_4 = 2 \left(\frac{R_1}{2} + R_3 \right) + R_3$$

or, using values

$$R_4 = 2 \left(\frac{1 \text{ M}\Omega}{2} + 266 \text{ k}\Omega \right) \cong 1.5 \text{ M}\Omega$$



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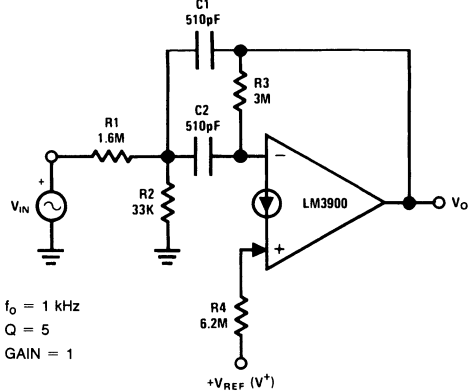
FIGURE 37. Biasing Equivalent Circuit

6.4 A SINGLE-AMPLIFIER BANDPASS ACTIVE FILTER

The bandpass filter is perhaps the most interesting. For low frequencies, low gain and low Q (≤ 10) requirements, a single amplifier realization can be used. A one amplifier circuit is shown in Figure 38 and the design procedure is as follows;

Given: H_0 , Q and $\omega_0 = 2\pi f$.

To find: R_1, R_2, R_3, R_4, C_1 and C_2 .



$f_0 = 1 \text{ kHz}$
 $Q = 5$
 GAIN = 1

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FIGURE 38. A One Op Amp Bandpass Filter

Let $C_1 = C_2$ and select a convenient starting value.

Then

$$R_1 = \frac{Q}{H_0 \omega_0 C_1} \tag{8}$$

$$R_2 = \frac{Q}{(2Q^2 - H_0) \omega_0 C_1} \tag{9}$$

$$R_3 = \frac{2Q}{\omega_0 C_1} \tag{10}$$

and

$$R_4 = 2R_3 \text{ (for } V_{\text{REF}} = V^+) \tag{11}$$

As a design example:

Require: $H_0 = 1$

$Q = 5$

$f_0 = 1 \text{ kHz}$ ($\omega_0 = 6.28 \times 10^3 \text{ rps}$).

Start by selecting

$C_1 = C_2 = 510 \text{ pF}$.

Then using equation (8)

$$R_1 = \frac{5}{(6.28 \times 10^3)(5.1 \times 10^{-10})}$$

$$R_1 = 1.57 \text{ M}\Omega,$$

and using equation (9)

$$R_2 = \frac{5}{[2(25) - 1](6.28 \times 10^3)(5.1 \times 10^{-10})}$$

$$R_2 = 32 \text{ k}\Omega$$

from equation (10)

$$R_3 = \frac{2(5)}{(6.28 \times 10^3)(5.1 \times 10^{-10})}$$

$$R_3 = 3.13 \text{ M}\Omega,$$

and finally, for biasing, using equation (11)

$$R_4 = 6.2 \text{ M}\Omega.$$

6.5 A TWO-AMPLIFIER BANDPASS ACTIVE FILTER

To allow higher Q (between 10 and 50) and higher gain, a two amplifier filter is required. This circuit, shown in *Figure 39*, uses only two capacitors. It is similar to the previous single amplifier bandpass circuit and the added amplifier supplies a controlled amount of positive feedback to improve the response characteristics. The resistors R_5 and R_8 are used to bias the output voltage of the amplifiers at $V^+ / 2$.

Again, R_5 is simply chosen as twice R_4 and R_8 must be selected after R_6 and R_7 have been assigned values. The design procedure is as follows:

Given: Q and f_0

To find: R_1 through R_7 , and C_1 and C_2

Let: $C_1 = C_2$ and choose a convenient starting value and choose a value for K to reduce the spread of element values or to optimize sensitivity ($1 \leq K_{\text{Typically}} \leq 10$).

Then

$$R_1 = R_4 = R_6 = \frac{Q}{\omega_0 C_1} \quad (12)$$

$$R_2 = R_1 \frac{KQ}{(2Q - 1)} \quad (13)$$

$$R_3 = \frac{R_1}{Q^2 - 1 - 2/K + 1/KQ} \quad (14)$$

and

$$R_7 = KR_1 \quad (15)$$

$$H_0 = \sqrt{Q} K. \quad (16)$$

As a design example:

Require: $Q = 25$ and $f_0 = 1 \text{ kHz}$.

Select: $C_1 = C_2 = 0.1 \mu\text{F}$

and $K = 3$.

Then from equation (12)

$$R_1 = R_4 = R_6 = \frac{25}{(2\pi \times 10^3)(10^{-7})}$$

$$R_1 = 40 \text{ k}\Omega$$

and from equation (13)

$$R_2 = (40 \times 10^3) \frac{3(25)}{[2(25) - 1]}$$

$$R_2 = 61 \text{ k}\Omega$$

and from equation (14)

$$R_3 = \frac{40 \times 10^3}{(25)^2 - 1 - 2/3 + \frac{1}{3(25)}}$$

$$R_3 = 64 \Omega$$

And R_7 is given by equation (15)

$$R_7 = 3(40 \text{ k}\Omega) = 120 \text{ k}\Omega,$$

and the gain is obtained from equation (16)

$$H_0 = \sqrt{25}(3) = 15 (23 \text{ dB}).$$

To properly bias the first amplifier

$$R_5 = 2R_4 = 80 \text{ k}\Omega$$

and the second amplifier is biased by R_8 . Notice that the outputs of both amplifiers will be at $V^+ / 2$. Therefore R_6 and R_7 can be paralleled and

$$R_8 = 2(R_6 \parallel R_7)$$

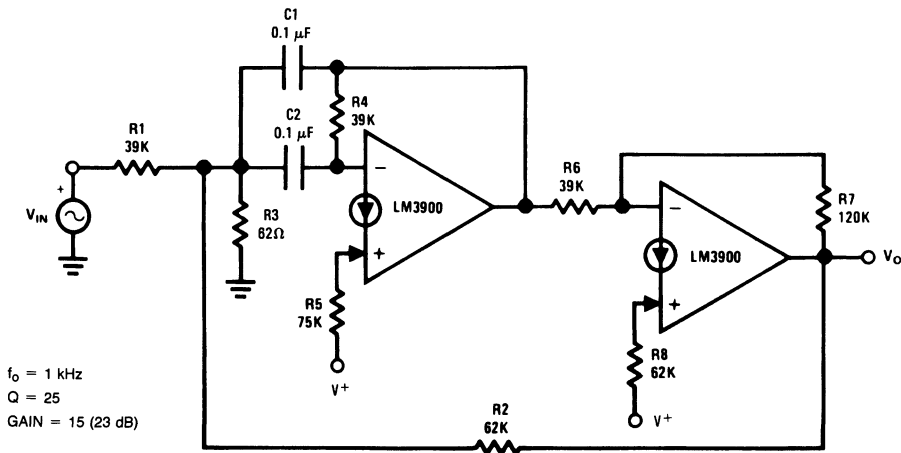
or

$$R_8 = 2 \left[\frac{(40)(120) \times 10^3}{160} \right] = 59 \text{ k}\Omega$$

These values, to the closest standard resistor values, have been added to *Figure 39*.

6.6 A THREE-AMPLIFIER BANDPASS ACTIVE FILTER

To reduce Q sensitivity to element variation even further or to provide higher Q ($Q > 50$) a three amplifier bandpass filter can be used. This circuit, *Figure 40*, pre-dates most of the literature on RC active filters and has been used on analog computers. Due to the use of three amplifiers it often is considered too costly—especially for low Q applications. The multiple amplifiers of the LM3900 make this a very useful circuit. It has been called the "Bi-Quad" as it can produce a transfer function which is "Quad"-ratic in both numerator and denominator (to give the "Bi"). A newer real-



$f_0 = 1 \text{ kHz}$
 $Q = 25$
 GAIN = 15 (23 dB)

FIGURE 39. A Two Op Amp Bandpass Filter

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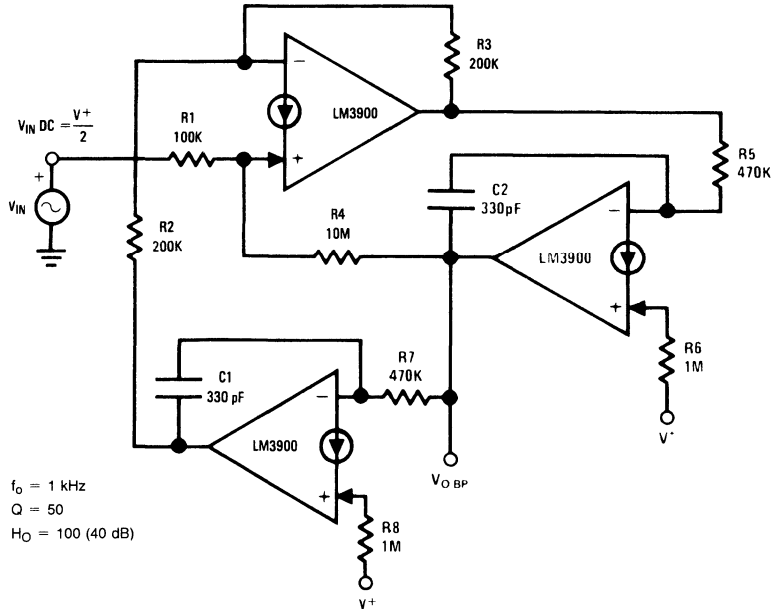


FIGURE 40. The "Bi-quad" RC Active Bandpass Filter

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ization technique for this type of filter is the "second-degree state-variable network." Outputs can be taken at any of three points to give low pass, high pass or bandpass response characteristics (see the reference cited).

The bandpass filter is shown in *Figure 40* and the design procedure is:

Given: Q and f_o .

To simplify: Let $C_1 = C_2$ and choose a convenient starting value and also let $2R_1 = R_2 = R_3$ and choose a convenient starting value.

Then:

$$R_4 = R_1 (2Q - 1), \quad (17)$$

$$R_5 = R_7 = \frac{1}{\omega_o C_1}, \quad (18)$$

and for biasing the amplifiers we require

$$R_6 = R_8 = 2R_5. \quad (19)$$

The mid-band gain is:

$$H_o = \frac{R_4}{R_1}. \quad (20)$$

As a design example;

Require: $f_o = 1 \text{ kHz}$ and $Q = 50$.

To find: C_1 , C_2 and R_1 through R_8 .

Choose: $C_1 = C_2 = 330 \text{ pF}$

and $2R_1 = R_2 = R_3 = 360 \text{ k}\Omega$, and $R_1 = 180 \text{ k}\Omega$.

Then from equation (17),

$$R_4 = (1.8 \times 10^5) [2(50) - 1]$$

$$R_4 = 17.8 \text{ M}\Omega$$

From equation (18),

$$R_5 = R_7 = \frac{1}{(2\pi \times 10^3) (3.3 \times 10^{-10})}$$

$$R_5 = 483 \text{ k}\Omega.$$

And from equation (19),

$$R_6 = R_8 \approx 1 \text{ M}\Omega.$$

From equation (20) the midband gain is 100 (40 dB). The value of R_4 is high and can be lowered by scaling only R_1 through R_4 by the factor 1.78 to give:

$$2R_1 = R_2 = R_3 = \frac{360 \times 10^3}{1.78} = 200 \text{ k}\Omega, R_1 = 100 \text{ k}\Omega.$$

and

$$R_4 = \frac{17.8 \times 10^6}{1.78} = 10 \text{ M}\Omega.$$

These values (to the nearest 5% standard) have been added to *Figure 40*.

6.7 CONCLUSIONS

The unity-gain cross frequency of the LM3900 is 2.5 MHz which is approximately three times that of a "741" op amp. The performance of the amplifier does limit the performance of the filter. Historically, RC active filters started with little

concern for these practical problems. The sensitivity functions were a big step forward as these demonstrated that many of the earlier suggested realization techniques for RC active filters had passive component sensitivity functions which varied as Q or even Q^2 . The Bi-Quad circuit has reduced the problems with the passive components (sensitivity functions of 1 or $1/2$) and recently the contributions of the amplifier on the performance of the filter are being investigated. An excellent treatment ("The Bi-Quad: Part I — Some Practical Design Considerations," L.C. Thomas, IEEE Transactions on Circuit Theory, Vol. CT-18, No. 3, May 1971) has indicated the limits imposed by the characteristics of the amplifier by showing that the design value of Q (Q_D) will differ from the actual measured value of Q (Q_A) by the given relationship

$$Q_A = \frac{Q_D}{1 + \frac{2Q_D}{A_O\omega_a}(\omega_a - 2\omega_p)} \quad (21)$$

where A_O is the open loop gain of the amplifier, ω_a is the dominant pole of the amplifier and ω_p is the resonant frequency of the filter. The result is that the trade-off between Q and center frequency (ω_p) can be determined for a given set of amplifier characteristics. When Q_A differs significantly from Q_D excessive dependence on amplifier characteristics is indicated. An estimate of the limitations of an amplifier can be made by arbitrarily allowing approximately a 10% effect on Q_A which results if

$$\frac{2Q_D}{A_O\omega_a}(\omega_a - 2\omega_p) = 0.1$$

or

$$\left(\frac{\omega_p}{\omega_a}\right) = 2.5 \times 10^{-2} \left(\frac{A_O}{Q_D}\right) + 0.5. \quad (22)$$

As an example, using $A_O = 2800$ for the LM3900 we can estimate the maximum frequency where a $Q_D = 50$ would be reasonable as

$$\frac{f_p}{f_a} = 2.5 \times 10^{-2} \left(\frac{2.8 \times 10^3}{5 \times 10}\right) + 0.5$$

or

$$\frac{f_p}{f_a} = 1.9$$

therefore

$$f_p = 1.9 f_a.$$

Again, using data of the LM3900, $f_a = 1$ kHz so this upper frequency limit is approximately 2 kHz for the assumed Q of 50. As indicated in equation (26) the value of Q_A can actually exceed the value of Q_D (Q enhancement) and, as expected, the filter can even provide its own input (oscillating). Excess phase shift in the high frequency characteristics of the amplifier typically cause unexpected oscillations. Phase compensation can be used in the Bi-Quad network to reduce this problem (see L.C. Thomas paper).

Designing for large passband gain also increases filter dependency on the characteristics of the amplifier and finally gain signal to noise ratio can usually be improved by taking gain in an input RC active filter (again see L.C. Thomas paper).

Somewhat larger Q 's can be achieved by adding more filter sections in either a synchronously tuned cascade (filters tuned to same center frequency and taking advantage of the bandwidth shrinkage factor which results from the series connection) or as a standard multiple pole filter. All of the conventional filters can be realized and selection is based upon all of the performance requirements which the application demands. The cost advantages of the LM3900, the relatively large bandwidth and the ease of operation on a single power supply voltage make this product an excellent "building block" for RC active filters.

7.0 Designing Waveform Generators

The multiple amplifiers of the LM3900 can be used to easily generate a wide variety of waveforms in the low frequency range ($f \leq 10$ kHz). Voltage controlled oscillators (VCO)'s are also possible and are presented in section 8.0 "Designing Phase-locked Loops and Voltage Controlled

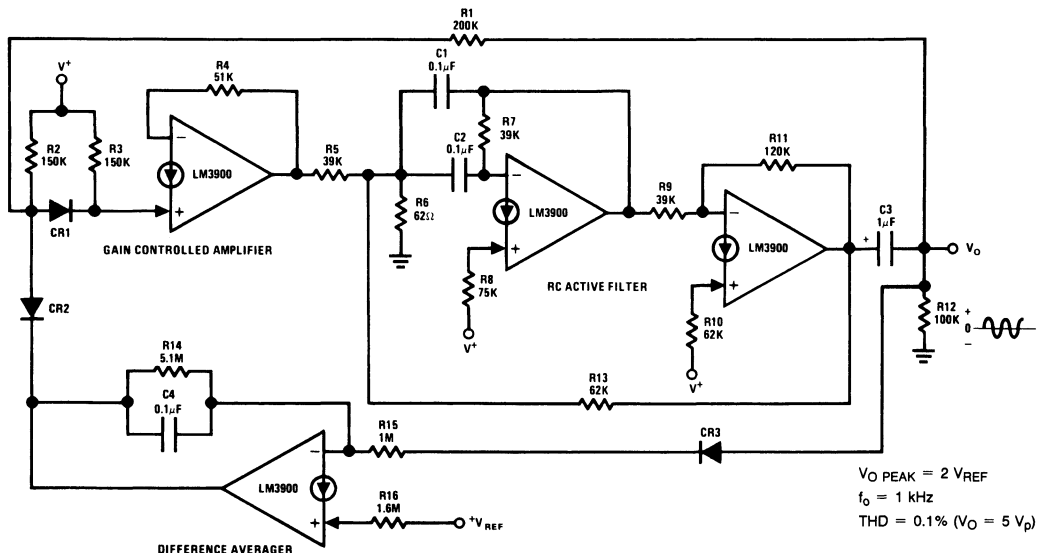


FIGURE 41. A Sinewave Oscillator

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Oscillators." In addition, power oscillators (such as noise makers, etc.) are presented in section 10.11.3. The waveform generators which will be presented in this section are mainly of the switching type, but for completeness a sine-wave oscillator has been included.

7.1 A SINEWAVE OSCILLATOR

The design of a sinewave oscillator presents problems in both amplitude stability (and predictability) and output waveform purity (THD). If an RC bandpass filter is used as a high Q resonator for the oscillator circuit we can obtain an output waveform with low distortion and eliminate the problem of relative center frequency drift which exists if the active filter were used simply to filter the output of a separate oscillator.

A sinewave oscillator which is based on this principle is shown in *Figure 41*. The two-amplifier RC active filter is used as it requires only two capacitors and provides an overall non-inverting phase characteristic. If we add a non-inverting gain controlled amplifier around the filter we obtain the desired oscillator configuration. Finally, the sinewave output voltage is sensed and regulated as the average value is compared to a DC reference voltage, V_{REF} , by use of a differential averaging circuit. It can be shown that with the values selected for R_{15} and R_{16} (ratio of 0.64/1) that there is first order temperature compensation for CR_3 and the internal input diodes of the IC amplifier which is used for the "difference averager". Further, this also provides a simple way to regulate and to predict the magnitude of the output sinewave as

$$V_O \text{ peak} = 2 V_{REF}$$

which is essentially independent of both temperature and the magnitude of the power supply voltage (if V_{REF} is derived from a stable voltage source).

7.2 SQUAREWAVE GENERATOR

The standard op amp squarewave generator has been modified as shown in *Figure 42*. The capacitor, C_1 , alternately

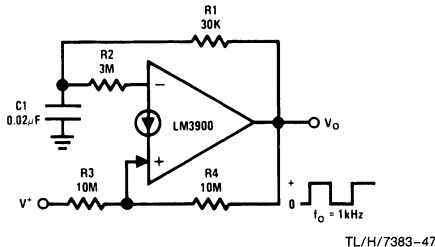


FIGURE 42. A Squarewave Oscillator

charges and discharges (via R_1) between the voltage limits which are established by the resistors R_2 , R_3 and R_4 . This combination produces a Schmitt Trigger circuit and the operation can be understood by noticing that when the output is low (and if we neglect the current flow through R_4) the resistor R_2 (3M) will cause the trigger to fire when the current through this resistor equals the current which enters the (+) input (via R_3). This gives a firing voltage of approximately $R_2/(R_3) V^+$ (or $V^+/3$). The other trip point, when the output voltage is high, is approximately $[2(R_2/R_3)] V^+$, as $R_3 = R_4$, or $2/3(V^+)$. Therefore the voltage across the capacitor, C_1 , will be the first one-half of an exponential waveform between these voltage trip limits and will have good symmetry and be essentially independent of the magnitude of the power supply voltage. If an unsymmetrical squarewave is desired, the trip points can be shifted to produce any desired mark/space ratio.

7.3 PULSE GENERATOR

The squarewave generator can be slightly modified to provide a pulse generator. The slew rate limits of the LM3900 ($0.5V/\mu\text{sec}$) must be kept in mind as this limits the ability to produce a narrow pulse when operating at a high power supply voltage level. For example, with a $+15 V_{DC}$ power supply the rise time, t_r , to change 15V is given by:

$$t_r = \frac{15V}{\text{Slew Rate}} = \frac{15V}{0.5V/\mu\text{sec}}$$

$$t_r = 30 \mu\text{sec}.$$

The schematic of a pulse generator is shown in *Figure 43*. A diode has been added, CR_1 , to allow separating the charge path to C_1 (via R_1) from the discharge path (via R_2). The

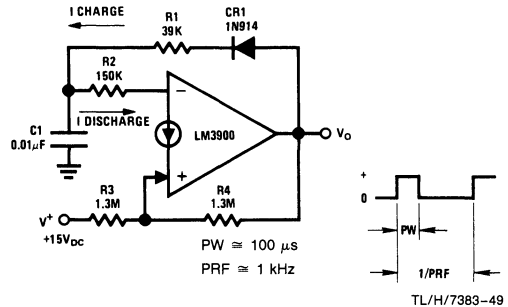


FIGURE 43. A Pulse Generator

circuit operates as follows: Assume first that the output voltage has just switched low (and we will neglect the current flow through R_4). The voltage across C_1 is high and the magnitude of the discharge current (through R_2) is given by

$$I_{\text{Discharge}} \approx \frac{V_{C_1} - V_{BE}}{R_2}.$$

This current is larger than that entering the (+) input which is given by

$$I_{R_3} = \frac{V^+ - V_{BE}}{R_3}.$$

The excess current entering the (-) input terminal causes the amplifier to be driven to a low output voltage state (saturation). This condition remains for the long time interval ($1/\text{Pulse Repetition Frequency}$) until the R_2C_1 discharge current equals the I_{R_3} value (as CR_1 is OFF during this interval). The voltage across C_1 at the trip point, V_L , is given by

$$V_L = (I_{R_3})(R_2),$$

or

$$V_L = (V^+ - V_{BE}) \left(\frac{R_2}{R_3} \right). \quad (1)$$

At this time the output voltage will switch to a high state, V_{OH} , and the current entering the (+) input will increase to

$$I_{M^+} = \frac{V^+ - V_{BE}}{R_3} + \frac{V_{OH} - V_{BE}}{R_4}.$$

Also CR₁ goes ON and the capacitor, C₁, charges via R₁. Some of this charge current is diverted via R₂ to ground (the (-) input is at V_{CE SAT} during this interval as the current mirror is demanding more current than the (-) input terminal can provide). The high trip voltage, V_H, is given by

$$V_H = (I_M^+) R_2 \quad \text{or} \\ V_H = \left(\frac{V^+ - V_{BE}}{R_3} + \frac{V_{OHI} - V_{BE}}{R_4} \right) R_2. \quad (2)$$

A design proceeds by first choosing the trip points for the voltage across C₁. The resistors R₃ and R₄ are used only for this trip voltage control. The resistor R₂ affects the discharge time (the long interval) and also both of the trip voltages so this resistor is determined first from the required pulse repetition frequency (PRF). The value of R₂ is determined by the RC exponential discharge from V_H to V_L as this time interval, T₁, controls the PRF (T₁ = 1/PRF). If we start with the equation for the RC discharge we have

$$V_L = V_H e^{-\frac{T_1}{R_2 C_1}}$$

or

$$\ln \frac{V_L}{V_H} = -\frac{T_1}{R_2 C_1}$$

or

$$T_1 = R_2 C_1 \ln \frac{V_H}{V_L} \quad (3)$$

To provide a low duty cycle pulse train we select small values for both V_H and V_L (such as 3V and 1.5V) and choose a starting value for C₁. Then R₂ is given by

$$R_2 = \frac{T_1}{C_1 \ln \frac{V_H}{V_L}}. \quad (4)$$

If R₂ from (4) is not in the range of approximately 100 kΩ to 1 MΩ, choose another value for C₁. Now equation (1) can be used to find a value for R₃ to provide the V_L which was initially assumed. Similarly equation (2) allows R₄ to be calculated. Finally R₁ is determined by the required pulse width (PW) as the capacitor, C₁, must be charged from V_L to V_H by R₁. This RC charging is given by (neglecting the loading due to R₂)

$$V_H \cong (V_{OHI} - V_D) \left(1 - e^{-\frac{T_2}{R_1 C_1}} \right)$$

or

$$T_2 \cong -R_1 C_1 \ln \left[1 - \frac{V_H}{V_{OHI} - V_D} \right], \text{ and finally} \\ R_1 \cong \frac{T_2}{-C_1 \ln \left[1 - \frac{V_H}{V_{OHI} - V_D} \right]} \quad (5)$$

where T₂ is the pulse width desired and V_D is the forward voltage drop across CR₁.

As a design example:

Required: Provide a 100 μs pulse every 1 ms. The power supply voltage is +15 V_{DC}

1.0 Start by choosing V_L = 1.5V

and V_H = 3.0V

2.0 Find R₂ from equation (4) assuming C₁ = 0.01 μF,

$$R_2 = \frac{10^{-3}}{10^{-8} \ln \left(\frac{3.0}{1.5} \right)} \\ R_2 = \frac{10^5}{0.694} = 144 \text{ k}\Omega$$

3.0 Find R₃ from equation (1)

$$R_3 = \frac{(V^+ - V_{BE}) R_2}{V_L} \\ R_3 = \frac{(15 - 0.5) 1.44 \times 10^5}{1.5} \\ R_3 = 1.39 \text{ M}\Omega$$

4.0 Find R₄ from equation (2),

$$R_4 = \frac{(V_{OHI} - V_{BE})}{\frac{V_H}{R_2} - \frac{V^+ - V_{BE}}{R_3}} \\ R_4 = \frac{(14.2 - 0.5)}{\frac{3}{1.44 \times 10^5} - \frac{15 - 0.5}{1.39 \times 10^6}} \\ R_4 = 1.32 \text{ M}\Omega$$

5.0 Find R₁ from equation (5),

$$R_1 = \frac{10^{-4}}{-10^{-8} \ln \left(1 - \frac{3}{(14.2 - 0.7)} \right)} \\ R_1 = \frac{10^4}{-\ln \left(1 - \frac{3}{13.5} \right)} \\ R_1 = \frac{10^4}{0.252} = 39.7 \text{ k}\Omega.$$

These values (to the nearest 5% standard) have been added to Figure 43.

7.4 TRIANGLE WAVEFORM GENERATOR

Triangle waveforms are usually generated by an integrator which receives first a positive DC input voltage, then a negative DC input voltage. The LM3900 easily provides this operation in a system which operates with only a single power supply voltage by making use of the current mirror which exists at the (+) input. This allows the generation of a triangle waveform without requiring a negative DC input voltage. The schematic diagram of a triangle waveform generator is shown in Figure 44. One amplifier is doing the integration by

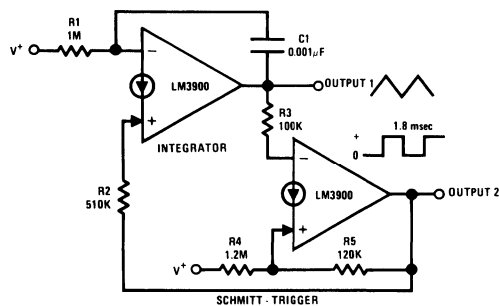


FIGURE 44. A Triangle Waveform Generator

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operating first with the current through R_1 to produce the negative output voltage slope, and then when the output of the second amplifier (the Schmitt Trigger) is high, the current through R_2 causes the output voltage to increase. If $R_1 = 2R_2$, the output waveform will have good symmetry. The timing for one-half of the period ($T/2$) is given by

$$\frac{T}{2} = \frac{(R_1 C_1) \Delta V_O}{V^+ - V_{BE}}$$

or the output frequency becomes

$$f_o = \frac{V^+ - V_{BE}}{2R_1 C_1 \Delta V_O}$$

where we have assumed $R_1 = 2R_2$, V_{BE} is the DC voltage at the (-) input ($0.5 V_{DC}$), and ΔV_O is the difference between the trip points of the Schmitt Trigger. The design of the Schmitt Trigger has been presented in the section on Digital and Switching Circuits (9.0) and the trip voltages control the peak-to-peak excursion of the triangle output voltage waveform. The output of the Schmitt circuit provides a squarewave of the same frequency.

7.5 SAWTOOTH WAVEFORM GENERATOR

The previously described triangle waveform generator, *Figure 44*, can be modified to produce a sawtooth waveform. Two types of waveforms can be provided, both a positive ramp and a negative ramp sawtooth waveform by selecting R_1 and R_2 . The reset time is also controlled by the ratio of R_1 and R_2 . For example, if $R_1 = 10 R_2$ a positive ramp sawtooth results and if $R_2 = 10 R_1$ a negative ramp sawtooth can be obtained. Again, the slew rate limits of the amplifier ($0.5V/\mu s$) will limit the minimum retrace time, and the increased slew rate of a negative going output will allow a faster retrace for a positive ramp sawtooth waveform.

To provide a gated sawtooth waveform, the circuits shown in *Figure 45* can be used. In *Figure 45(a)*, a positive ramp is generated by integrating the current, I , which is entering the (+) input. Reset is provided via R_1 and CR_1 keeps R_1 from loading at the (-) input during the sweep interval. This will sweep from $V_O \text{ MIN}$ to $V_O \text{ MAX}$ and will remain at $V_O \text{ MAX}$ until reset. The interchange of the input leads, *Figure 45(b)*, will generate a negative ramp, from $V_O \text{ MAX}$ to $V_O \text{ MIN}$.

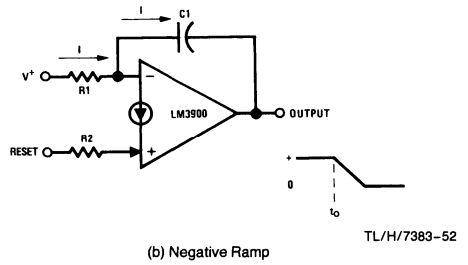
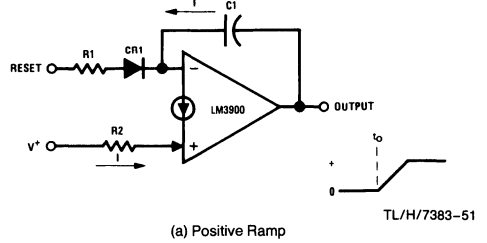


FIGURE 45. Gated Sawtooth Generators

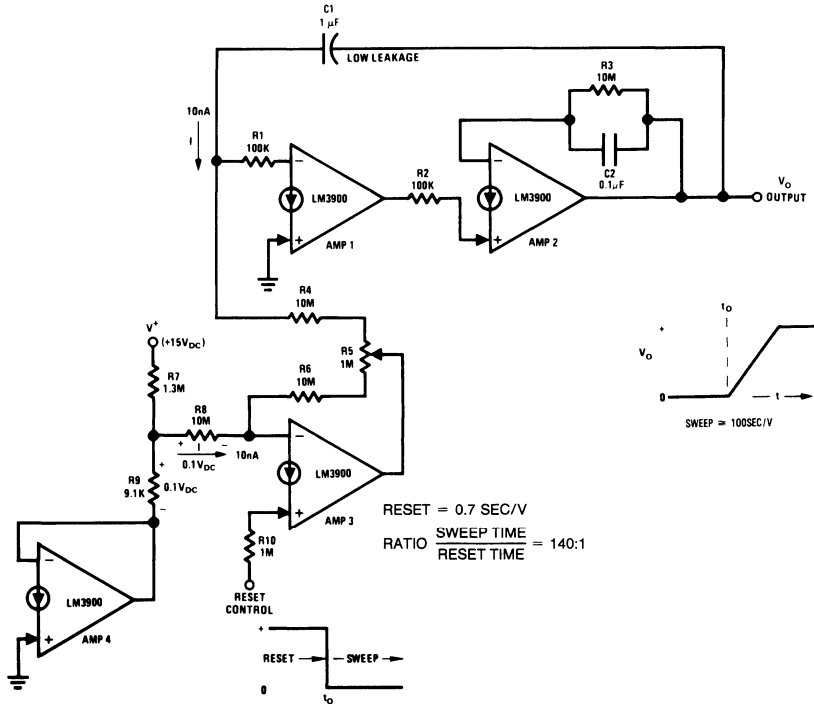


FIGURE 46. Generating Very Slow Sawtooth Waveforms

7.5.1 GENERATING A VERY SLOW SAWTOOTH WAVEFORM

The LM3900 can be used to generate a very slow sawtooth waveform which can be used to generate long time delay intervals. The circuit is shown in *Figure 46* and uses four amplifiers. Amps 1 and 2 are cascaded to increase the gain of the integrator and the output is the desired very slow sawtooth waveform. Amp 3 is used to exactly supply the bias current to Amp 1.

With resistor R_8 opened up and the reset control at zero volts, the potentiometer, R_5 , is adjusted to minimize the drift in the output voltage of Amp 2 (this output must be kept in the linear range to insure that Amp 2 is not in saturation). Amp 4 is used to provide a bias reference which equals the DC voltage at the (-) input of Amp 3. The resistor divider, R_7 and R_9 provides a $0.1 V_{DC}$ reference voltage across R_9 which also appears across R_8 . The current which flows through R_8 , I , enters the (-) input of Amp 3 and causes the current through R_6 to drop by this amount. This causes an imbalance as now the current flow through R_4 is no longer adequate to supply the input current of Amp 1. The net result is that this same current, I , is drawn from capacitor C_1 and causes the output voltage of Amp 2 to sweep slowly positive. As a result of the high impedance values used, the PC component board used for this circuit must first be cleaned and then coated with silicone rubber to eliminate the effects of leakage currents across the surface of the board. The DC leakage currents of the capacitor, C_1 , must also be small compared to the 10 nA charging current. For example, an insulation resistance of 100,000 M Ω will leak 0.1 nA with 10 V_{DC} across the capacitor and this leakage rapidly increases at higher temperatures. Dielectric polarization of the dielectric material may not cause problems if the circuit is not rapidly cycled. The resistor, R_8 , and the capacitor, C_1 , can be scaled to provide other basic sweep rates. For the values shown on *Figure 46* the 10 nA current and the 1 μF capacitor establish a sweep rate of 100 sec/volt. The reset control pulse (Amp 3 (+) input) causes Amp 3 to go to the positive output saturation state and the 10 M Ω (R_4) gives a reset rate of 0.7 sec/volt. The resistor, R_1 , prevents a large discharge current of C_1 from overdriving the (-) input and overloading the input clamp device. For larger charging currents, a resistor divider can be placed from the output of Amp 4 to ground and R_8 can tie from this tap point directly to the (-) input of Amp 1.

7.6 STAIRCASE WAVEFORM GENERATORS

A staircase generator can be realized by supplying pulses to an integrator circuit. The LM3900 also can be used with a squarewave input signal and a differentiating network where each transition of the input squarewave causes a step in the output waveform (or two steps per input cycle). This is shown in *Figure 47*. These pulses of current are the charge and discharge currents of the input capacitor, C_1 . The charge current, I_c , enters the (+) input and is mirrored about ground and is "drawn into" the (-) input. The discharge current, I_D , is drawn through the diode at the input, CR_1 , and therefore also causes a step on the output staircase.

A free running staircase generator is shown in *Figure 48*. This uses all four of the amplifiers which are available in one LM3900 package.

Amp 1 provides the input pulses which "pump up" the staircase via resistor R_1 (see section 7.3 for the design of this pulse generator). Amp 2 does the integrate and hold function and also supplies the output staircase waveform. Amps 3 and 4 provide both a compare and a one-shot multivibrator function (see the section on Digital and Switching Circuits for the design of this dual function one-shot). Resistor R_4 is used to sample the staircase output voltage and to compare it with the power supply voltage (V^+) via R_3 . When the output exceeds approximately 80% of V^+ the connection of Amps 3 and 4 causes a 100 μ sec reset pulse to be generated. This is coupled to the integrator (Amp 2) via R_2 and causes the staircase output voltage to fall to approximately zero volts. The next pulse out of Amp 1 then starts a new stepping cycle.

7.7 A PULSE COUNTER AND A VOLTAGE VARIABLE PULSE COUNTER

The basic circuit of *Figure 48* can be used as a pulse counter simply by omitting Amp 1 and feeding input voltage pulses directly to R_1 . A simpler one-shot/comparator which requires only one amplifier can also be used in place of Amps 3 and 4 (again, see the section on Digital and Switching Circuits). To extend the time interval between pulses, an additional amplifier can be used to supply base current to Amp 2 to eliminate the tendency for the output voltage to drift up due to the 30 nA input current (see section 7.5.1). The pulse count can be made voltage variable simply by removing the comparator reference (R_3) from V^+ and using this as a control voltage input. Finally, the input could be derived from differentiating a squarewave input as was shown in *Figure 47* and if only one step per cycle were desired, the diode, CR_1 of *Figure 47*, can be eliminated.

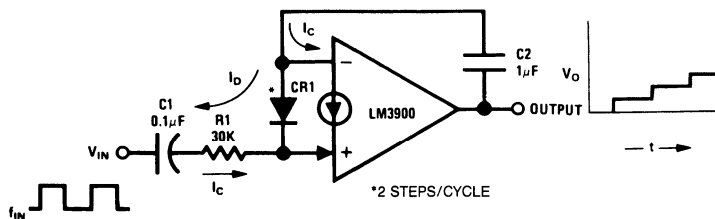


FIGURE 47. Pumping the Staircase Via Input Differentiator

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7.8 AN UP-DOWN STAIRCASE WAVEFORM GENERATOR

A staircase waveform which first steps up and then steps down is provided by the circuit shown in *Figure 49*. An input pulse generator provides the pulses which cause the output to step up or down depending on the conduction of the clamp transistor, Q₁. When this is ON, the "down" cur-

rent pulse is diverted to ground and the staircase then steps "up". When the upper voltage trip point of Amp 2 (Schmitt Trigger—see section on Digital and Switching Circuits) is reached, Q₁ goes OFF and as a result of the smaller "down" input resistor (one-half the value of the "up" resistor, R₁) the staircase steps "down" to the low voltage trip point of Amp 2. The output voltage therefore steps up and down between the trip voltages of the Schmitt Trigger.

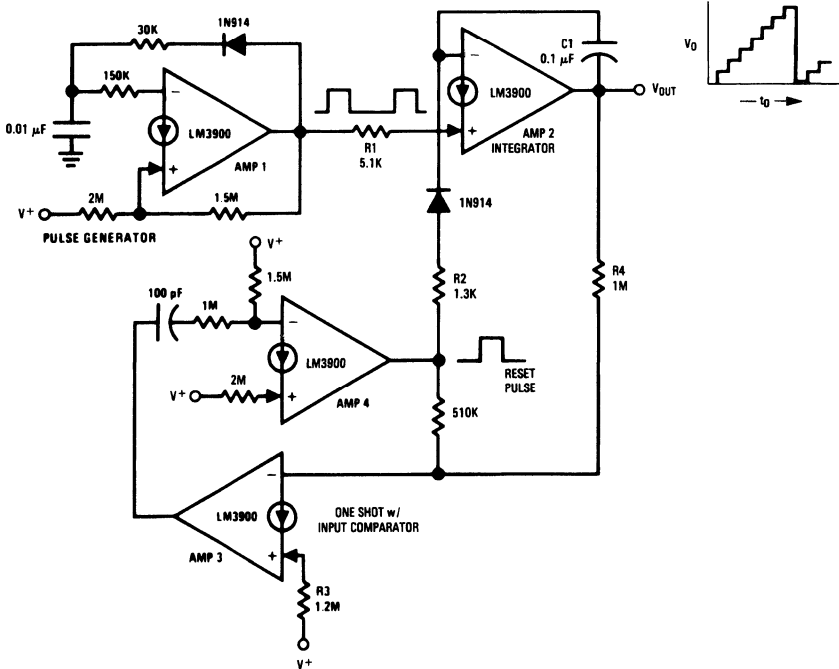


FIGURE 48. A Free Running Staircase Generator

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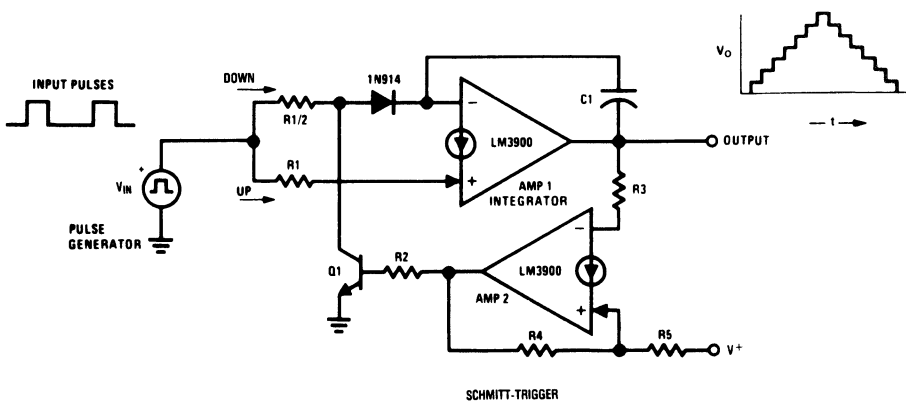


FIGURE 49. An Up-down Staircase Generator

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8.0 Designing Phase-Locked Loops and Voltage Controlled Oscillators

The LM3900 can be connected to provide a low frequency ($f < 10$ kHz) phase-locked loop (PLL). This is a useful circuit for many control applications. Tracking filters, frequency to DC converters, FM modulators and demodulators are applications of a PLL.

8.1 VOLTAGE CONTROLLED OSCILLATORS (VCO)

The heart of a PLL is the voltage controlled oscillator (VCO). As the PLL can be used for many functions, the required linearity of the transfer characteristic (frequency out vs. DC voltage in) depends upon the application. For low distortion demodulation of an FM signal, a high degree of linearity is necessary whereas a tracking filter application would not require this performance in the VCO.

A VCO circuit is shown in *Figure 50*. Only two amplifiers are required, one is used to integrate the DC input control voltage, V_C , and the other is connected as a Schmitt-trigger which monitors the output of the integrator. The trigger circuit is used to control the clamp transistor, Q_1 . When Q_1 is conducting, the input current, I_2 , is shunted to ground. During this one-half cycle the input current, I_1 , causes the output voltage of the integrator to ramp down. At the minimum point of the triangle waveform (output 1), the Schmitt circuit changes state and transistor Q_1 goes OFF. The current, I_2 , is exactly twice the value of I_1 ($R_2 = R_1/2$) such that a charge current (which is equal to the magnitude of the discharge current) is drawn through the capacitor, C , to provide the increasing portion of the triangular waveform (output 1).

The output frequency for a given DC input control voltage depends on the trip voltages of the Schmitt circuit (V_H and V_L) and the components R_1 and C_1 (as $R_2 = R_1/2$). The

time to ramp down from V_H to V_L corresponds to one-half the period (T) of the output frequency and can be found by starting with the basic equation of the integrator

$$V_O = -\frac{1}{C} \int I_1 dt \quad (1)$$

as I_1 is a constant (for a given value of V_C) which is given by

$$I_1 = \frac{V_C - V_{BE}}{R_1} \quad (2)$$

equation (1) simplifies to

$$\Delta V_O = -\frac{I_1}{C} (\Delta t)$$

or

$$\frac{\Delta V_O}{\Delta t} = -\frac{I_1}{C} \quad (3)$$

Now the time, Δt , to sweep from V_H to V_L becomes

$$\Delta t_1 = \frac{(V_H - V_L) C}{I_1} \quad \text{or}$$

$$T = \frac{2(V_H - V_L) C}{I_1} \quad \text{and}$$

$$f = \frac{1}{T} = \frac{I_1}{2(V_H - V_L) C} \quad (4)$$

Therefore, once V_H , V_L , R_1 and C are fixed in value, the output frequency, f , is a linear function of I_1 (as desired for a VCO).

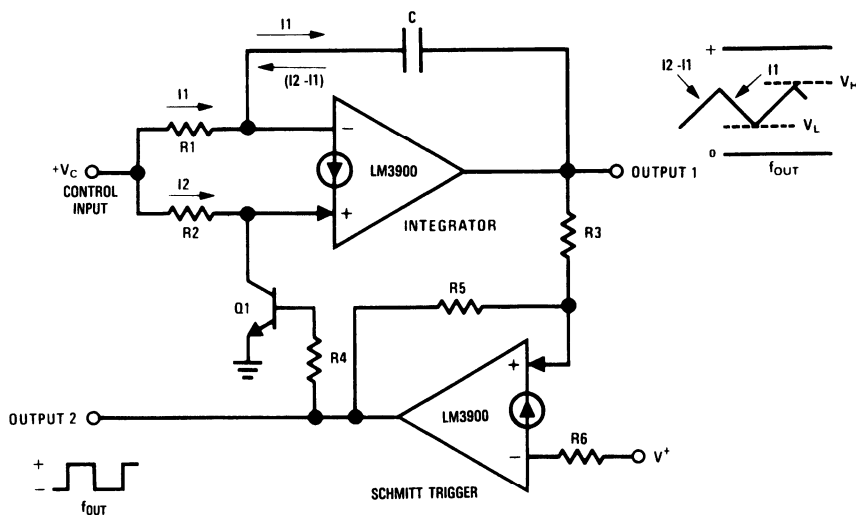
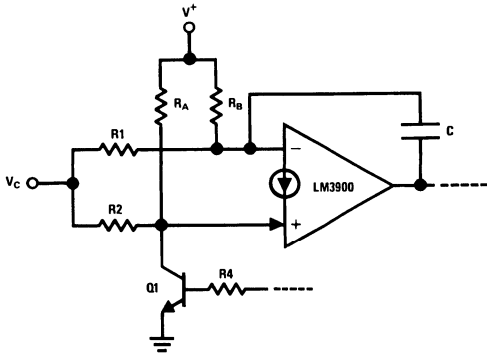


FIGURE 50. A Voltage Controlled Oscillator

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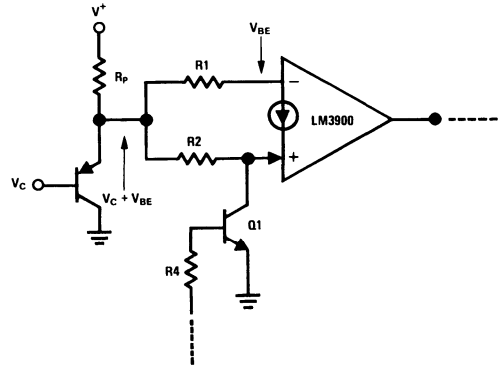


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FIGURE 51. Adding Input Common-mode Biasing Resistors

The circuit shown in *Figure 50* will require $V_C > V_{BE}$ to oscillate. A value of $V_C = 0$ provides $f_{OUT} = 0$, which may or may not be desired. Two common-mode input biasing resistors can be added as shown in *Figure 51* to allow $f_{OUT} = f_{MIN}$ for $V_C = 0$. In general, if these resistors are a factor of 10 larger than their corresponding resistor (R_1 or R_2) a large control frequency ratio can be realized. Actually, V_C could range outside the supply voltage limit of V^+ and this circuit will still function properly.

The output frequency of this circuit can be increased by reducing the peak-to-peak excursion of the triangle waveform (output 1) by design of the trip points of the Schmitt circuit. A limit is reached when the triangular sweep output waveform exceeds the slew rate limit of the LM3900 (0.5 V/ μ s). Note that the output of the Schmitt circuit has to move up only one V_{BE} to bring the clamp transistor, Q_1 , ON, and therefore output slew rate of this circuit is not a limit.



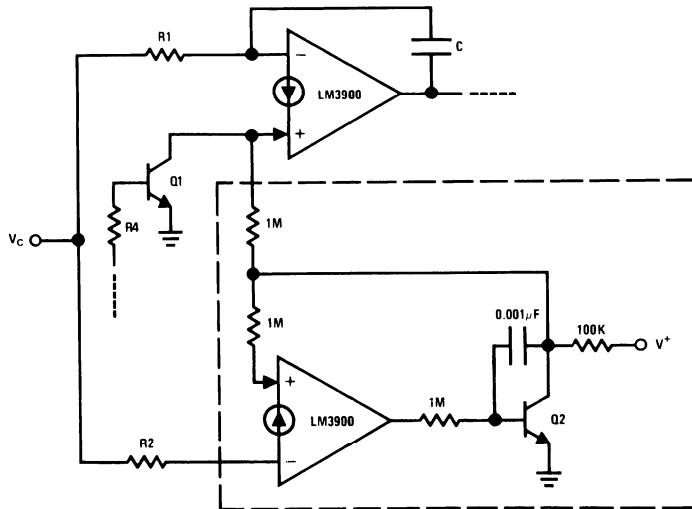
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FIGURE 52. Reducing Temperature Drift

To improve the temperature stability of the VCO, a PNP emitter follower can be used to give approximate compensation for the V_{BE} 's at the inputs to the amplifier (see *Figure 52*). Finally to improve the mark to space ratio accuracy over temperature and at low control voltages, an additional amplifier can be added such that both reference currents are applied to the same type of (inverting) inputs of the LM3900. The circuit to accomplish this is shown within dotted lines in *Figure 53*.

8.2 PHASE COMPARATOR

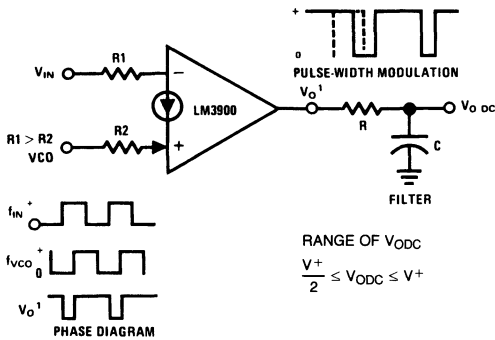
A basic phase comparator is shown in *Figure 54*. This circuit provides a pulse-width modulated output voltage waveform, V_{O1} , which must be filtered to provide a DC output voltage (this filter can be the same as the one needed in the PL²). The resistor R_2 is made smaller than R_1 so the (+) input serves to inhibit the (-) input signal. The center of the



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FIGURE 53. Improving Mark/Space Ratio

dynamic range is indicated by the waveforms shown on the figure (90° phase difference between f_{IN} and f_{VCO}).



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FIGURE 54. Phase Comparator

The filtered DC output voltage will center at $3V^+/4$ and can range from $V^+/2$ to V^+ as the phase error ranges from 0 degrees to 180 degrees.

8.3 A COMPLETE PHASE-LOCKED LOOP

A phase-locked loop can be realized with three of the amplifiers as shown in Figure 55. This has a center frequency of approximately 3 kHz. To increase the lock range, DC gain can be added at the input to the VCO by using the fourth amplifier of the LM3900. If the gain is inverting, the limited DC dynamic range out of the phase detector can be in-

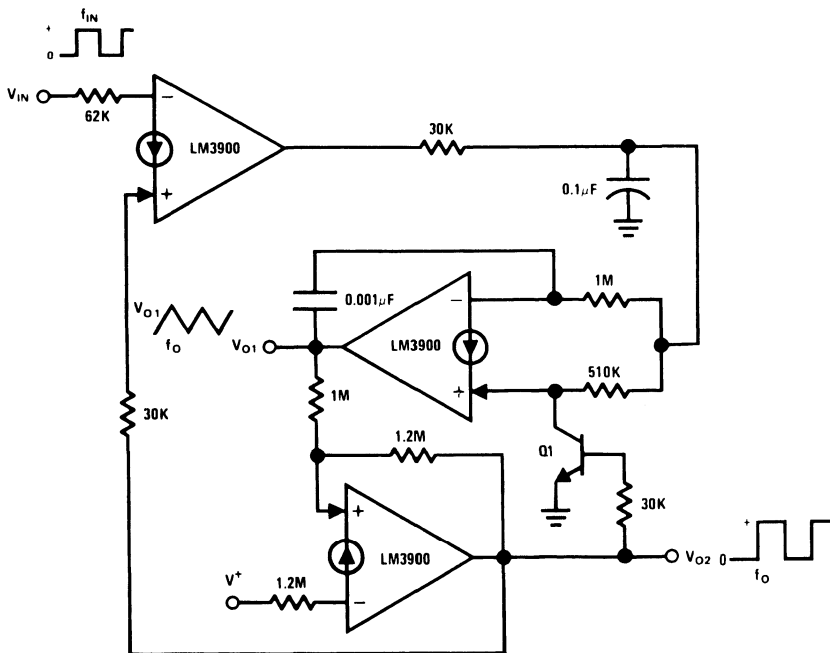
creased to improve the frequency lock range. With inverting gain, the input to the VCO could go to zero volts. This will cause the output of the VCO to go high (V^+) and will latch if applied to the (+) input of the phase comparator. Therefore apply the VCO signal to the (-) input of the phase comparator or add the common-mode biasing resistors of Figure 57.

8.4 CONCLUSIONS

One LM3900 package (4 amplifiers) can provide all of the operations necessary to make a phase-locked loop. In addition, a VCO is a generally useful component for other system applications.

9.0 Designing Digital and Switching Circuits

The amplifiers of the LM3900 can be over-driven and used to provide a large number of low speed digital and switching circuit applications for control systems which operate off of single power supply voltages larger than the standard $+5 V_{DC}$ digital limit. The large voltage swing and slower speed are both advantages for most industrial control systems. Each amplifier of the LM3900 can be thought of as "a super transistor" with a β of 1,000,000 (25 nA input current and 25 mA output current) and with a non-inverting input feature. In addition, the active pull-up and pull-down which exists at the output will supply larger currents than the simple resistor pull-ups which are used in digital logic gates. Finally, the low input currents allow timing circuits which minimize the capacitor values as large impedance levels can be used with the LM3900.

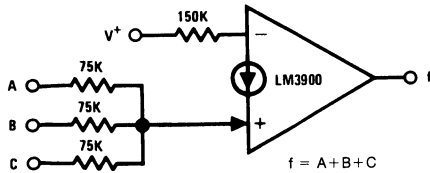


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FIGURE 55. A Phase-locked Loop

9.1 AN "OR" GATE

An OR gate can be realized by the circuit shown in *Figure 56*. A resistor (150 k Ω) from V^+ to the (-) input keeps the output of the amplifier in a low voltage saturated state for all inputs A, B, and C at 0V. If any one of the input signals were to go high ($\cong V^+$) the current flow through the 75 k Ω input resistor will cause the amplifier to switch to the positive output saturation state ($V_O \cong V^+$). The current loss through the other input resistors (which have an input in the low voltage state) represents an insignificant amount of the total input current which is provided by the, at least one, high voltage input. More than three inputs can be OR'ed if desired.



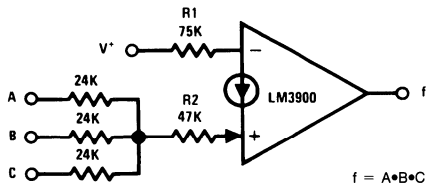
TL/H/7383-63

FIGURE 56. An "OR" Gate

The "fan-out" or logical drive capability is large (50 gates if each gate input has a 75 k Ω resistor) due to the 10 mA output current capability of the LM3900. A NOR gate can be obtained by interchanging the inputs to the LM3900.

9.2 AN "AND" GATE

A three input AND gate is shown in *Figure 57*. This gate requires all three inputs to be high in order to have sufficient current entering the (+) input to cause the output of the amplifier to switch high. The addition of R_2 causes a smaller current to enter the (+) input when only two of the inputs are high. (A two input AND gate would not require a resistor

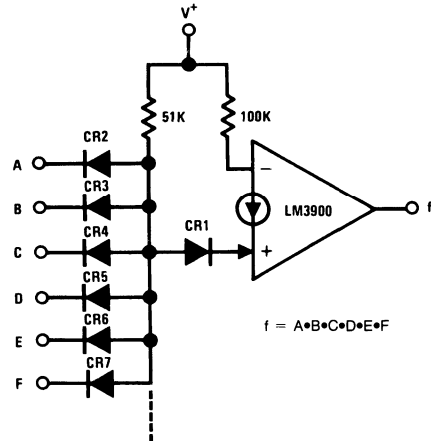


TL/H/7383-64

FIGURE 57. An "AND" Gate

as R_2). More than three inputs becomes difficult with this resistor summing approach as the (+) input is too close to having the necessary current to switch just prior to the last input going high. For a larger fan-in an input diode network

(similar to DTL) is recommended as shown in *Figure 58*. Interchange the inputs for a NAND gate.



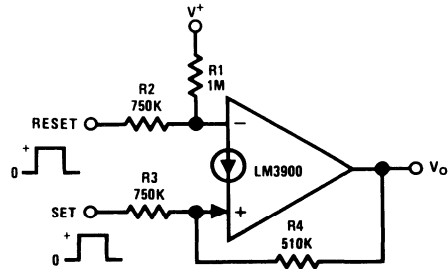
All Diodes 1N914 or Equiv.

TL/H/7383-65

FIGURE 58. A Large Fan-in "AND" Gate

9.3 A BI-STABLE MULTIVIBRATOR

A bi-stable multivibrator (as asynchronous RS flip-flop) can be realized as shown in *Figure 59*. Positive feedback is provided by resistor R_4 which causes the latching. A positive pulse at the "set" input causes the output to go high and a "reset" positive pulse will return the output to essentially 0V_{DC}.



TL/H/7383-66

FIGURE 59. A Bi-stable Multivibrator

9.4 TRIGGER FLIP FLOPS

Trigger flip flops are useful to divide an input frequency as each input pulse will cause the output of a trigger flip flop to change state. Again, due to the absence of a clocking signal input, this is for an asynchronous logic application. A circuit which uses only one amplifier is shown in Figure 60. Steering of the differentiated positive input trigger is provided by the diode CR2. For a low output voltage state, CR2 shunts the trigger away from the (-) input and resistor R₃ couples this positive input trigger to the (+) input terminal. This causes the output to switch high. The high voltage output state now keeps CR2 OFF and the smaller value of (R₅ + R₆) compared with R₃ causes a larger positive input trigger

to be coupled to the (-) input which causes the output to switch to the low voltage state.

A second trigger flip flop can be made which consists of two amplifiers and also provides a complementary output. This connection is shown in Figure 61.

9.5 MONOSTABLE MULTIVIBRATORS (ONE-SHOTS)

Monostable multivibrators can be made using one or two of the amplifiers of the LM3900. In addition, the output can be designed to be either high or low in the quiescent state. Further, to increase the usefulness, a one-shot can be designed which triggers at a particular DC input voltage level to serve the dual role of providing first a comparator and then a pulse generator.

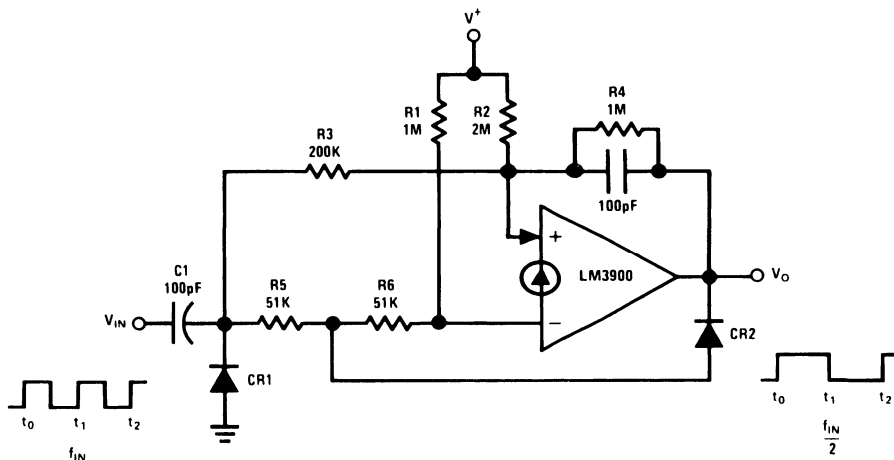


FIGURE 60. A Trigger Flip Flop

TL/H/7383-67

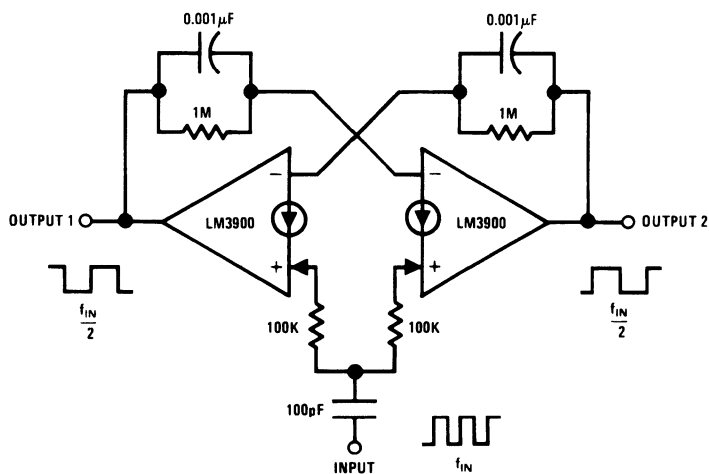


FIGURE 61. A Two-amplifier Trigger Flip Flop

TL/H/7383-68

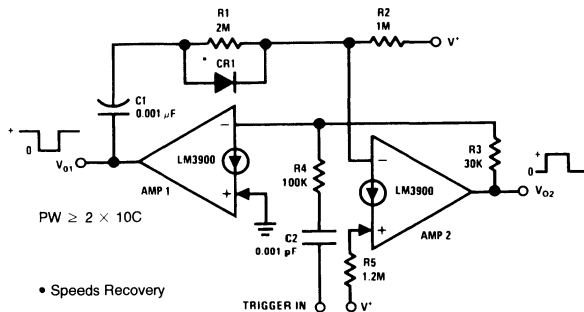


FIGURE 62. A One-shot Multivibrator

TL/H/7383-69

9.5.1 A TWO-AMPLIFIER ONE-SHOT

A circuit for a two-amplifier one-shot is shown in *Figure 62*. As the resistor, R_2 , from V^+ to the (-) input is smaller than R_5 (from V^+ to the (+) input), amplifier 2 will be biased to a low-voltage output in the quiescent state. As a result, no current is supplied to the (-) input of amplifier 1 (via R_3) which causes the output of this amplifier to be in the high voltage state. Capacitor C_1 therefore has essentially the full V^+ supply voltage across it ($V^+ - 2 V_{BE}$). Now when a differentiated trigger (due to C_2) causes amplifier 1 to be driven ON (output voltage drops to essentially zero volts) this negative transient is coupled (via C_1) to the (-) input of amplifier 2 which causes the output of this amplifier to be driven high (to positive saturation). This condition remains while C_1 discharges via (R_4) from approximately V^+ to approximately $V^+/2$. This time interval is the pulse width (PW). After C_1 no longer diverts sufficient current of R_2 away from the (-) input of amplifier 2 (i.e., C_1 is discharged to approximately $V^+/2$ V) the stable DC state is restored—amplifier 2 output low and amplifier 1 output high.

This circuit can be rapidly re-triggered due to the action of the diode, CR_1 . This re-charges C_1 as amplifier 1 drives full output current capability (approximately 10 mA) through C_1 , CR_1 and into the saturated (-) input of amplifier 2 to ground. The only time limit is the 10 mA available from amplifier 1 and the value of C_1 . If a rapid reset is not required, CR_1 can be omitted.

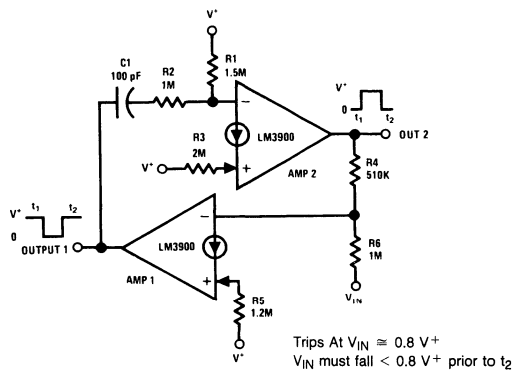


FIGURE 63. A One-shot Multivibrator with an Input Comparator

TL/H/7383-70

9.5.2 A COMBINATION ONE-SHOT/COMPARATOR CIRCUIT

In many applications a pulse is required if a DC input signal exceeds a predetermined value. This exists in free-running oscillators where after a particular output level has been reached a reset pulse must be generated to recycle the oscillator. This double function is provided with the circuit of *Figure 63*. The resistors R_5 and R_6 of amplifier 1 provide the inputs to a comparator and, as shown, an input signal, V_{IN} , is compared with the supply voltage, V^+ . The output voltage of amplifier 1 is normally in a high voltage state and will fall and initiate the generation of the output pulse when V_{IN} is $R_6/R_5 V^+$ or approximately 80% of V^+ . To keep V_{IN} from disturbing the pulse generation it is required that V_{IN} fall to less than the trip voltage prior to the termination of the output pulse. This is the case when this circuit is used to generate a reset pulse and therefore this causes no problems.

9.5.3 A ONE-AMPLIFIER ONE-SHOT (POSITIVE PULSE)

A one-shot circuit can be realized using only one amplifier as shown in *Figure 64*.

The resistor R_2 keeps the output in the low voltage state. A differentiated positive trigger causes the output to switch to the high voltage state and resistor R_5 latches this state. The capacitor, C_1 , charges from essentially ground to approximately $V^+/4$ where the circuit latches back to the quiescent state. The diode, CR_1 , is used to allow a rapid re-triggering.

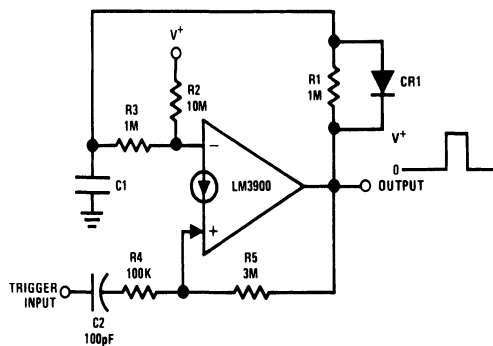


FIGURE 64. A One-amplifier One-shot (Positive Output)

TL/H/7383-71

9.5.4 A ONE-AMPLIFIER ONE-SHOT (NEGATIVE PULSE)

A one-amplifier one-shot multivibrator which has a quiescent state with the output high and which falls to zero volts for the pulse duration is shown in *Figure 65*.

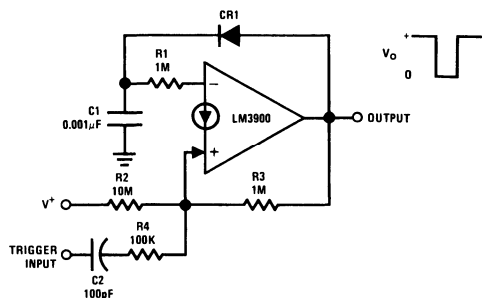


FIGURE 65. A One-Amplifier One-Shot (Negative Output)

TL/H/7383-72

The sum of the currents through R_2 and R_3 keeps the $(-)$ input at essentially ground. This causes V_O to be in the high voltage state. A differentiated negative trigger waveform causes the output to switch to the low voltage state. The large voltage across C_1 now provides input current via R_1 to keep the output low until C_1 is discharged to approximately $V^+ / 10$. At this time the output switches to the stable high voltage state.

If the R_4C_2 network is moved to the $(-)$ input terminal, the circuit will trigger on a differentiated positive trigger waveform.

9.6 COMPARATORS

The voltage comparator is a function required for most system operations and can easily be performed by the LM3900. Both an inverting and a non-inverting comparator can be obtained.

9.6.1 A COMPARATOR FOR POSITIVE INPUT VOLTAGES

The circuit in *Figure 66* is an inverting comparator. To insure proper operation, the reference voltage must be larger than

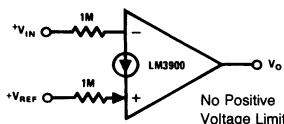


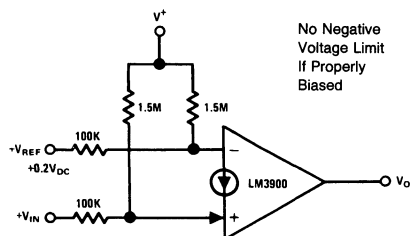
FIGURE 66. An Inverting Voltage Comparator

TL/H/7383-73

V_{BE} , but there is no upper limit as long as the input resistor is large enough to guarantee that the input current will not exceed $200 \mu A$.

9.6.2 A COMPARATOR FOR NEGATIVE INPUT VOLTAGES

Adding a common-mode biasing network to the comparator in *Figure 66* makes it possible to compare voltages between zero and one volt as well as the comparison of rather large negative voltages, *Figure 67*. When working with negative voltages, the current supplied by the common-mode network must be large enough to satisfy both the current drain demands of the input voltages and the bias current requirement of the amplifier.

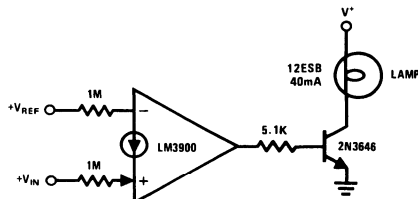


TL/H/7383-74

FIGURE 67. A Non-inverting Low-voltage Comparator

9.6.3 A POWER COMPARATOR

When used in conjunction with an external transistor, this power comparator will drive loads which require more current than the IC amplifier is capable of supplying. *Figure 68* shows a non-inverting comparator which is capable of driving a 12V, 40 mA panel lamp.



TL/H/7383-75

FIGURE 68. A Non-inverting Power Comparator

9.6.4 A MORE PRECISE COMPARATOR

A more precise comparator can be designed by using a second amplifier such that the input voltages of the same type of inputs are compared. The $(-)$ input voltages of two amplifiers are naturally more closely matched initially and track well with temperature changes. The comparator of *Figure 69* uses this concept.

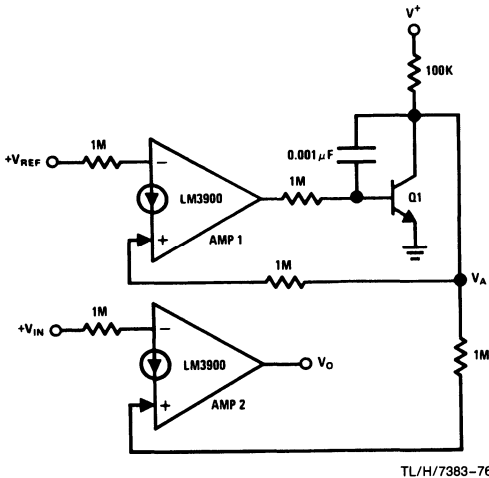


FIGURE 69. A More Precise Comparator

The current established by V_{REF} at the inverting input of amplifier 1 will cause transistor Q_1 to adjust the value of V_A to supply this current. This value of V_A will cause an equal current to flow into the non-inverting input of amplifier 2. This current corresponds more exactly to the reference current of amplifier 1.

A differential input stage can also be added to the LM3900 (see section 10.16) and the resulting circuit can provide a precision comparator circuit.

9.7 SCHMITT TRIGGERS

Hysteresis may be designed into comparators which use the LM3900 as shown in Figure 70.

The lower switch point for the inverting Schmitt-Trigger is determined by the amount of current flowing into the positive input with the output voltage low. When the input current, I_3 , drops below the level required by the current mirror, the output will switch to the high limit. With V_O high, the current demanded by the mirror is increased by a fixed amount, I_2 . As a result, the I_3 required to switch the output increases this same amount. Therefore, the switch points are determined by selecting resistors which will establish the required currents at the desired input voltages. Reference current (I_1) and feedback current (I_2) are set by the following equation.

$$I_1 = \frac{V^+ - \phi}{R_B}$$

$$I_2 = \frac{V_O \text{ MAX} - \phi}{R_F}$$

By adjusting the values of R_B , R_F , and R_{IN} , the switching values of V_{IN} may be set to any levels desired.

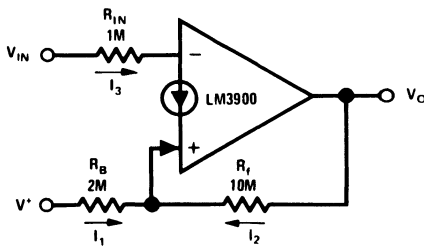
The non-inverting Schmitt Trigger works in the same way except that the input voltage is applied to the (+) input. The range of V_{IN} may be very large when compared with the operating voltage of the amplifier.

10.0 Some Special Circuit Applications

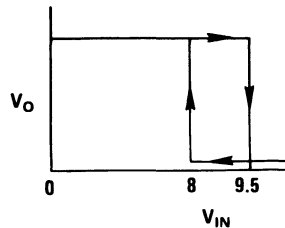
This section contains various special circuits which did not fit the order of things or which are one-of-a-kind type of applications.

10.1 CURRENT SOURCES AND SINKS

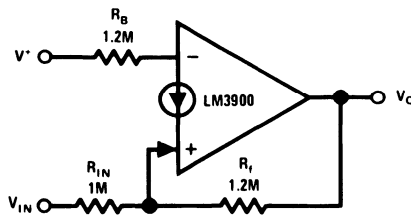
The amplifiers of the LM3900 can be used in feedback loops which regulate the current in external PNP transistors to provide current sources or in external NPN transistors to provide current sinks. These can be multiple sources or single sources which are fixed in value or made voltage variable.



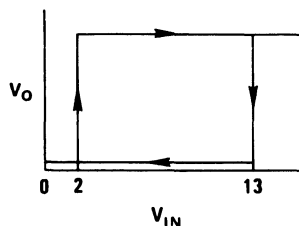
(a) Inverting



TL/H/7383-77



(b) Non-inverting



TL/H/7383-78

FIGURE 70. Schmitt Triggers

10.1.1 A FIXED CURRENT SOURCE

A multiple fixed current source is provided by the circuit of *Figure 71*. A reference voltage ($1 V_{DC}$) is established across resistor R_3 by the resistive divider (R_3 and R_4). Negative feedback is used to cause the voltage drop across R_1 to also be $1 V_{DC}$. This controls the emitter current of transistor Q_1 and if we neglect the small current diverted into the (-) input via the $1M$ input resistor ($13.5 \mu A$) and the base current of Q_1 and Q_2 (an additional 2% loss if the β of these transistors is 100), essentially this same current is available out of the collector of Q_1 .

Larger input resistors can be used to reduce current loss and a Darlington connection can be used to reduce errors due to the β of Q_1 .

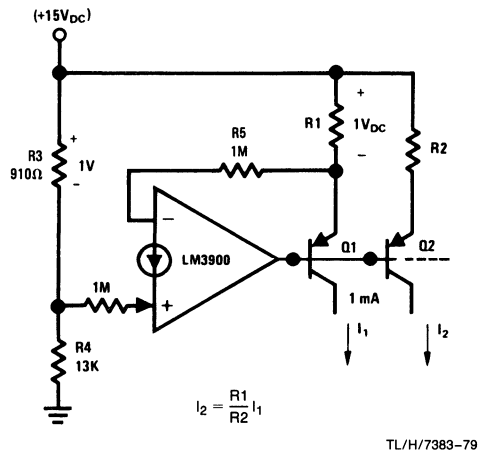


FIGURE 71. Fixed Current Sources

The resistor, R_2 , can be used to scale the collector current of Q_2 either above or below the 1 mA reference value.

10.1.2 A VOLTAGE VARIABLE CURRENT SOURCE

A voltage variable current source is shown in *Figure 72*. The transconductance is $-(1/R_2)$ as the voltage gain from the input terminal to the emitter of Q_1 is -1 . For a $V_{IN} = 0 V_{DC}$ the output current is essentially zero mA DC. The resistors R_1 and R_6 guarantee that the amplifier can turn OFF transistor Q_1 .

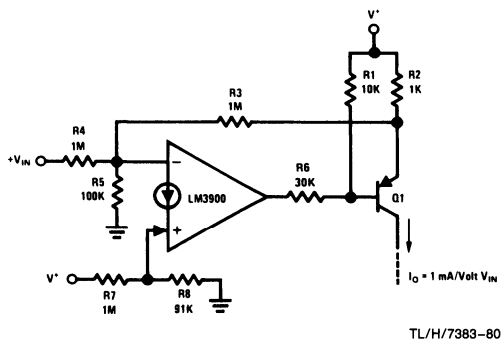
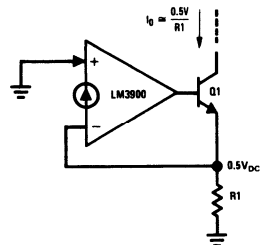


FIGURE 72. A Voltage Controlled Current Source

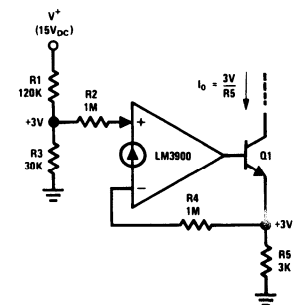
10.1.3 A FIXED CURRENT SINK

Two current sinks are shown in *Figure 73*. The circuit of *Figure 73(a)* requires only one resistor and supplies an out-

put current which is directly proportional to this R value. A negative temperature coefficient will result due to the $0.5 V_{DC}$ reference being the base-emitter junction voltage of the (-) input transistor. If this temperature coefficient is objectionable, the circuit of *Figure 73(b)* can be employed.



(a) A Simple Current Sink



(b) Reducing Temperature Drift Of I_0

FIGURE 73. Fixed Current Sinks

10.1.4 A VOLTAGE VARIABLE CURRENT SINK

A voltage variable current sink is shown in *Figure 74*. The output current is 1 mA per volt of V_{IN} (as $R_5 = 1 k\Omega$ and the gain is $+1$). This circuit provides approximately 0 mA output current for $V_{IN} = 0 V_{DC}$.

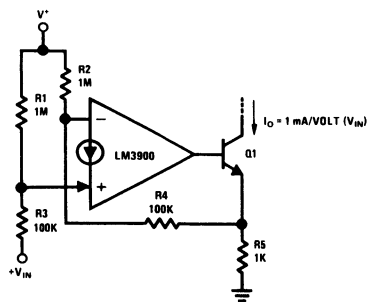


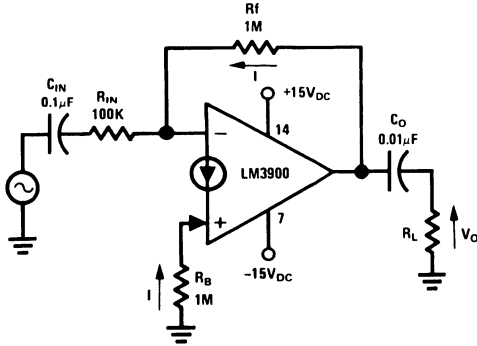
FIGURE 74. A Voltage Controlled Current Sink

10.2 OPERATION FROM $\pm 15 V_{DC}$ POWER SUPPLIES

If the ground pin (no. 7) is returned to a negative voltage and some changes are made in the biasing circuits, the LM3900 can be operated from $\pm 15 V_{DC}$ power supplies.

10.2.1 AN AC AMPLIFIER OPERATING WITH ± 15 V_{DC} POWER SUPPLIES

An AC coupled amplifier is shown in *Figure 75*. The biasing resistor, R_B , is now returned to ground and both inputs bias at one V_{BE} above the $-V_{EE}$ voltage (approximately -15 V_{DC}).



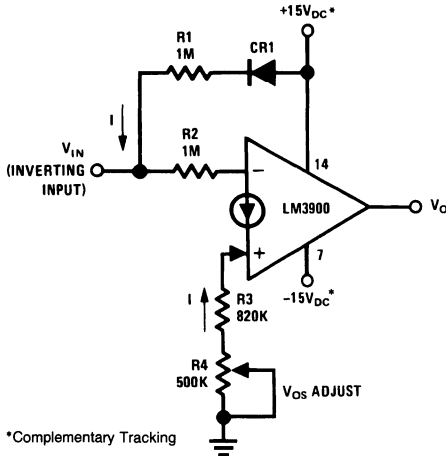
TL/H/7383-84

FIGURE 75. An AC Amplifier Operating With ± 15 V_{DC}

With $R_f = R_B$, V_O will bias at approximately 0 V_{DC} to allow a maximum output voltage swing. As pin 7 is common to all four of the amplifiers which are in the same package, the other amplifiers are also biased for operation off of ± 15 V_{DC}.

10.2.2 A DC AMPLIFIER OPERATING WITH ± 15 V_{DC} POWER SUPPLIES

Biasing a DC amplifier is more difficult and requires that the \pm power supplies be complementary tracking (i.e., $|+V_{CC}| = |-V_{EE}|$). The operation of this biasing can be understood if we start by first considering the amplifier without including the feedback resistors, as shown in *Figure 76*. If $R_1 = R_2 = R_3 + R_4 = 1$ M Ω and $|+V_{CC}| = |-V_{EE}|$,

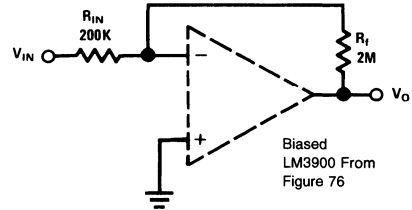


*Complementary Tracking

TL/H/7383-85

FIGURE 76. DC Biasing for ± 15 V_{DC} Operation

then the current, I , will bias V_{IN} at zero volts DC (resistor R_4 can be used to adjust this). The diode, CR_1 , has been added for temperature compensation of this biasing. Now, if we include these biasing resistors, we have a DC amplifier with the input biased at approximately zero volts. If feedback resistors are added around this biased amplifier we get the schematic shown in *Figure 77*.



TL/H/7383-86

FIGURE 77. A DC Amplifier Operating with ± 15 V_{DC}

This is a standard inverting DC amplifier connection. The (+) input is "effectively" at ground and the biasing shown in *Figure 76* is used to take care of DC levels at the inputs.

10.3 TACHOMETERS

Many pulse averaging tachometers can be built using the LM3900. Inputs can be voltage pulses, current pulses or the differentiated transitions of squarewaves. The DC output voltage can be made to increase with increasing input frequency, can be made proportional to twice the input frequency (frequency doubling for reduced output ripple), and can also be made proportional to either the sum or the difference between two input frequencies. Due to the small bias current and the high gain of the LM3900, the transfer function is linear between the saturation states of the amplifier.

10.3.1 A BASIC TACHOMETER

If an RC averaging network is added from the output to the (-) input, the basic tachometer of *Figure 78* results. Current pulse inputs will provide the desired transfer function shown on the figure. Each input current pulse causes a small change in the output voltage. Neglecting the effects of R we have

$$\Delta V_O \approx \frac{I \Delta t}{C}$$

The inclusion of R gives a discharge path so the output voltage does not continue to integrate, but rather provides the time dependency which is necessary to average the input pulses. If an additional signal source is simply placed in parallel with the one shown, the output becomes proportional to the sum of these input frequencies. If this additional source were applied to the (-) input, the output voltage would be proportional to the difference between these input frequencies. Voltage pulses can be converted to current pulses by using an input resistor. A series isolating diode should be used if a signal is applied to the (-) input to prevent loading during the low voltage state of this input signal.

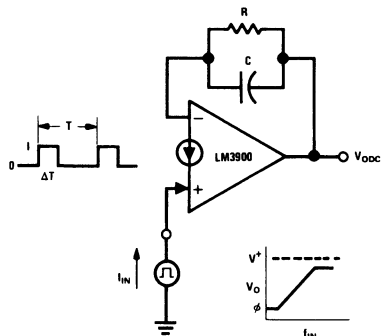


FIGURE 78. A Basic Tachometer

TL/H/7383-87

10.3.2 EXTENDING $V_{O_{UT}}$ (MINIMUM) TO GROUND

The output voltage of the circuit of *Figure 78* does not go to ground level but has a minimum value which is equal to the V_{BE} of the (-) input ($0.5 V_{DC}$). If it is desired that the output voltage go exactly to ground, the circuit of *Figure 79* can be used. Now with $V_{IN} = 0 V_{DC}$, $V_O = 0 V_{DC}$ due to the addition of the common-mode biasing resistors ($180 k\Omega$).

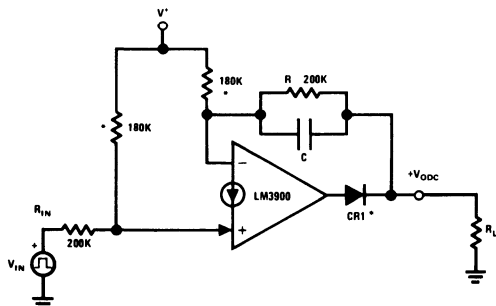


FIGURE 79. Adding Biasing to Provide $V_O = 0 V_{DC}$

TL/H/7383-88

The diode, CR_1 , allows the output to go below $V_{CE SAT}$ of the output, if desired (a load is required to provide a DC path for the biasing current flow via the R of the averaging network).

10.3.3 A FREQUENCY DOUBLING TACHOMETER

To reduce the ripple on the DC output voltage, the circuit of *Figure 80* can be used to effectively double the input frequency. Input pulses are not required, a squarewave is all that is needed. The operation of the circuit is to average the charge and discharge transient currents of the input capacitor, C_{IN} . The resistor, R_{IN} , is used to convert the voltage pulses to current pulses and to limit the surge currents (to approximately $200 \mu A$ peak—or less if operating at high temperatures).

When the input voltage goes high, the charging current of C_{IN} , I_{CHG} enters the (+) input, is mirrored about ground and is drawn from the RC averaging network into the (-) input terminal. When the input voltage goes back to ground, the

discharge current of C_{IN} , $I_{DISCHARGE}$ will also be drawn from the RC averaging network via the now conducting diode, CR_1 . This full wave action causes two current pulses to be drawn through the RC averaging network for each cycle of the input frequency.

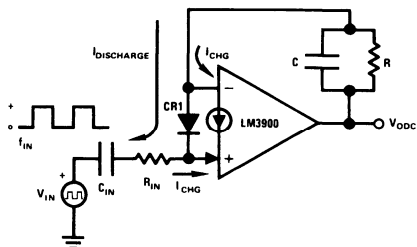
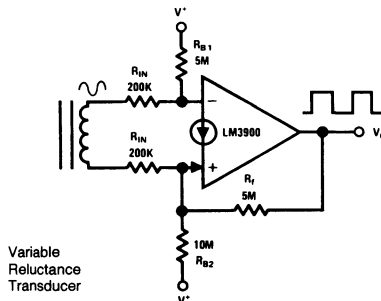


FIGURE 80. A Frequency Doubling Tachometer

TL/H/7383-89

10.4 A SQUARING AMPLIFIER

A squaring amplifier which incorporates symmetrical hysteresis above and below the zero output state (for noise immunity) is often needed to amplify the low level signals which are provided by variable reluctance transducers. In addition, a high frequency roll-off (low pass characteristic) is desirable both to reduce the natural voltage buildup at high frequencies and to also filter high frequency input noise disturbances. A simple circuit which accomplishes this function is shown in *Figure 81*. The input voltage is converted to



Variable
Reluctance
Transducer

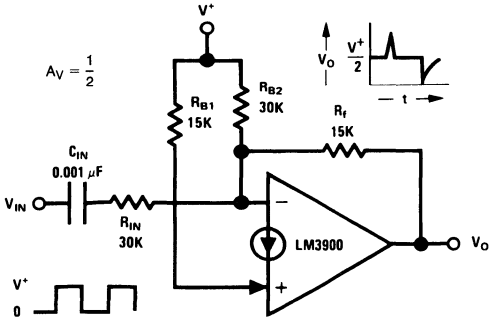
FIGURE 81. A Squaring Amplifier with Hysteresis

TL/H/7383-90

input currents by using the input resistors, R_{IN} . Common-mode biasing is provided by R_{B1} and R_{B2} . Finally positive feedback (hysteresis) is provided by R_f . The large source resistance, R_{IN} , provides a low pass filter due to the "Miller-effect" input capacitance of the amplifier (approximately $0.002 \mu F$). The amount of hysteresis and the symmetry about the zero volt input are controlled by the positive feedback resistor, R_f , and R_{B1} and R_{B2} . With the values shown in *Figure 81* the trip voltages are approximately $\pm 150 mV$ centered about the zero output voltage state of the transducer (at low frequencies where the low pass filter is not attenuating the input signal).

10.5 A DIFFERENTIATOR

An input differentiating capacitor can cause the input of the LM3900 to swing below ground and actuate the input clamp circuit. Again, common-mode biasing can be used to prevent this negative swing at the input terminals of the LM3900. The schematic of a differentiator circuit is shown in *Figure 82*. Common-mode biasing is provided by R_{B1} and



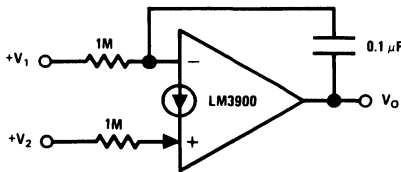
TL/H/7383-91

FIGURE 82. A Differentiator Circuit

R_{B2} . The feedback resistor, R_f , is one-half the value of R_{IN} so the gain is 1/2. The output voltage will bias at $V^+/2$ which thereby allows both a positive and a negative swing above and below this bias point. The resistor, R_{IN} , keeps the negative swing isolated from the (-) input terminal and therefore both inputs remain biased at $+V_{BE}$.

10.6 A DIFFERENCE INTEGRATOR

A difference integrator is the basis of many of the sweep circuits which can be realized using the LM3900 operating on only a single power supply voltage. This circuit can also be used to provide the time integral of the difference between two input waveforms. The schematic of the difference integrator is shown in *Figure 83*.



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FIGURE 83. A Difference Integrator

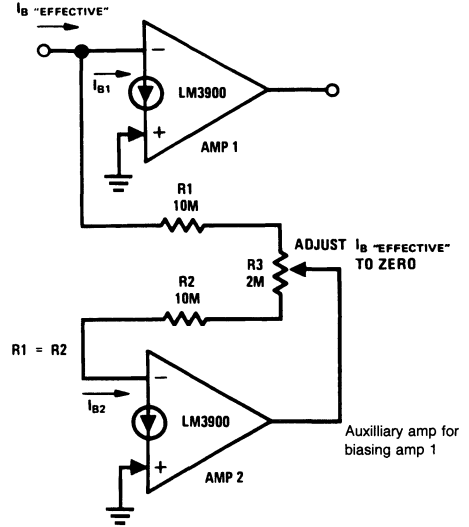
This is a useful component for DC feedback loops as both the comparison to a reference and the integration take place in one amplifier.

10.7 A LOW DRIFT SAMPLE AND HOLD CIRCUIT

In sample and hold applications a very low input biasing current is required. This is usually achieved by using a FET transistor or a special low input current IC op amp. The existence of many matched amplifiers in the same package allows the LM3900 to provide some interesting low "equivalent" input biasing current applications.

10.7.1 REDUCING THE "EFFECTIVE" INPUT BIASING CURRENT

One amplifier can be used to bias one or more additional amplifiers as shown in *Figure 84*.



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FIGURE 84. Reducing I_B "Effective" to Zero

The input terminal of Amp. 1 will only need to supply the signal current if the DC biasing current, I_{B1} , is accurately supplied via R_1 . The adjustment, R_3 , allows a zeroing of " I_B effective" but simply omitting R_3 and letting $R_1 = R_2$ (and relying on amplifier symmetry) can cause I_B "effective" to be less than $I_B/10$ (3 nA). This is useful in circuit applications such as sample and hold, where small values of I_B "effective" are desirable.

10.7.2 A LOW DRIFT RAMP AND HOLD CIRCUIT

The input current reduction technique of the previous section allows a relatively simple ramp and hold circuit to be built which can be ramped up or down or allowed to remain at any desired output DC level in a "hold" mode. This is shown in *Figure 85*. If both inputs are at 0 V_{DC} the circuit is in a hold mode. Raising either input will cause the DC output voltage to ramp either up or down depending on which one goes positive. The slope is a function of the magnitude of the input voltage and additional inputs can be placed in parallel, if desired, to increase the input control variables.

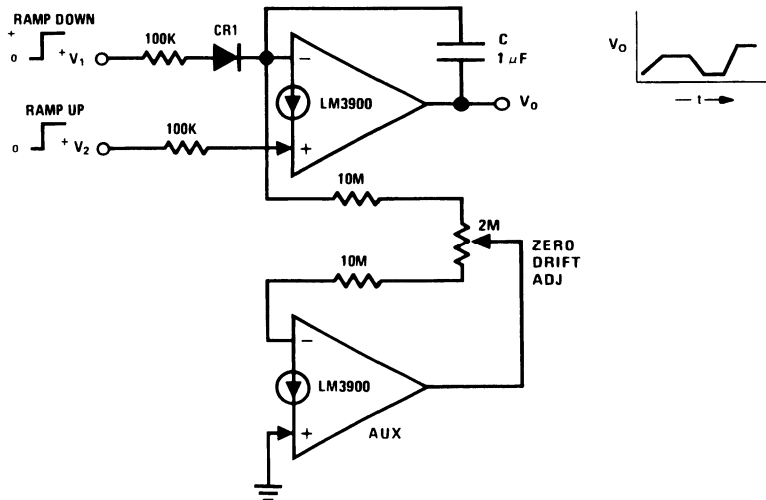


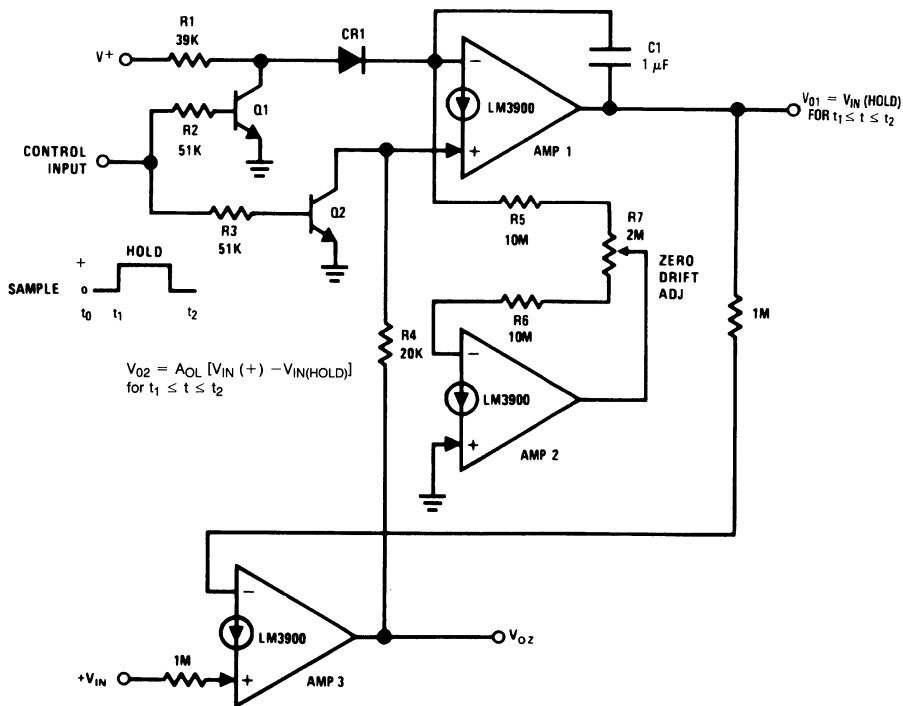
FIGURE 85. A Low-Drift Ramp and Hold Circuit

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10.7.3 SAMPLE-HOLD AND COMPARE WITH NEW $+V_{IN}$

An example of using the circuit of the previous section is shown in *Figure 86* where clamping transistors, Q_1 and Q_2 , put the circuit in a hold mode when they are driven ON. When OFF the output voltage of Amp. 1 can ramp either up or down as needed to guarantee that the output voltage of

Amp. 1 is equal to the DC input voltage which is applied to Amp. 3. Resistor R_1 provides a fixed "down" ramp current which is balanced or controlled via the comparator, Amp. 3, and the resistor R_4 . When Q_1 and Q_2 are OFF a feedback loop guarantees that V_{O1} (from Amp. 1) is equal to $+V_{IN}$ (to Amp. 3). Amplifier 2 is used to supply the input biasing current to Amp. 1.

FIGURE 86. Sample-Hold and Compare with New $+V_{IN}$

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The stored voltage appears at the output, V_{O1} of Amp. 1, and as Amp. 3 is active, a continued comparison is made between V_{O1} and V_{IN} and the output of Amp. 3 fully switches based on this comparison. A second loop could force V_{IN} to be maintained at the stored value (V_{O1}) by making use of V_{O2} as an error signal for this second loop. Therefore, a control system could be manually controlled to bring it to a particular operating condition; then, by exercising the hold control, the system would maintain this operating condition due to the analog memory provided by V_{O1} .

10.8 AUDIO MIXER OR CHANNEL SELECTOR

The multiple amplifiers of the LM3900 can be used for audio mixing (many amplifiers simultaneously providing signals which are added to generate a composite output signal) or for channel selection (only one channel enabled at a time).

Three amplifiers are shown being summed into a fourth amplifier in *Figure 87*.

If a power amplifier were available, all four amplifiers could feed the single input of the power amplifier. For audio mixing all amplifiers are simultaneously active. Particular amplifiers can be gated OFF by making use of DC control signals which are applied to the (+) inputs to provide a channel select feature. As shown on *Figure 87*, Amp. 3 is active (as sw 3 is closed) and Amps. 1 and 2 are driven to positive output voltage saturation by the 5.1M which is applied to the (+) inputs. The DC output voltage bias level of the active amplifier is approximately $0.8 V_{DC}$ and could be raised if larger signal levels were to be accommodated. Frequency shaping networks can be added either to the individual amplifiers or to the common amplifier, as desired. Switching transients may need to be filtered at the DC control points if the output amplifier is active during the switching intervals.

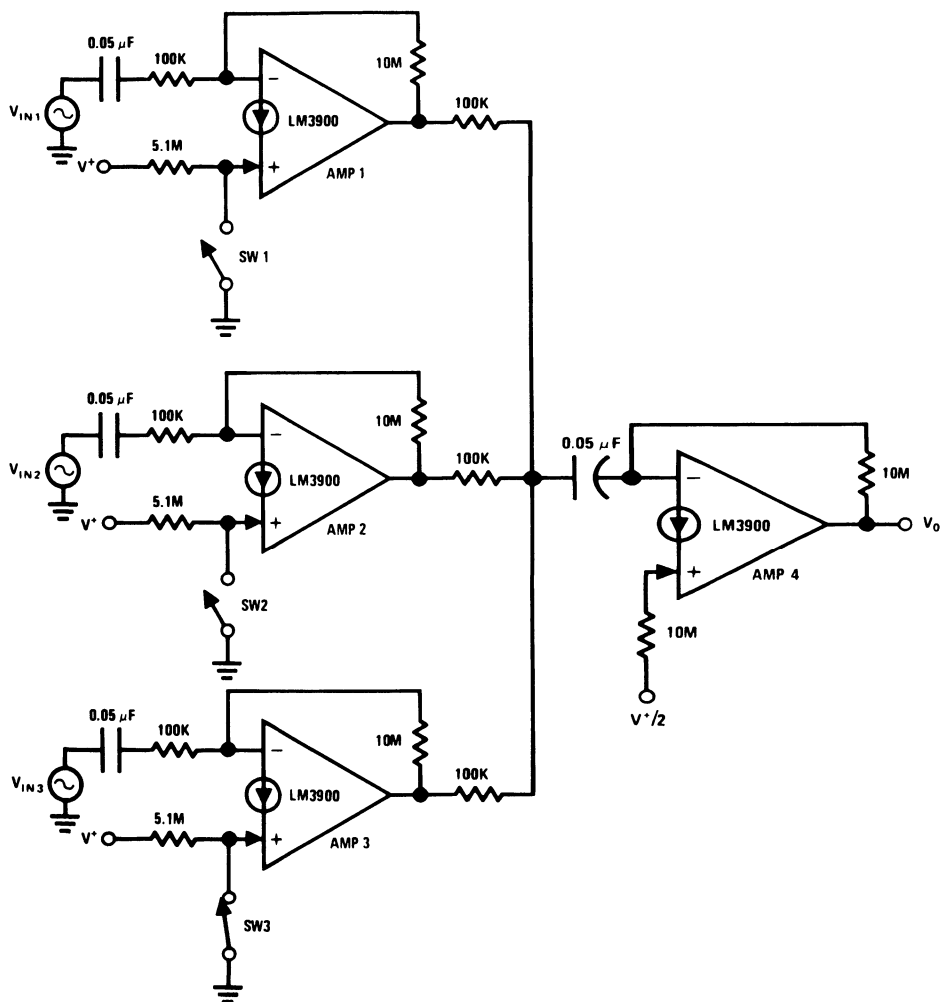
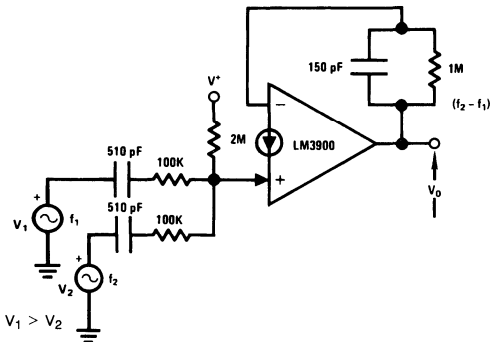


FIGURE 87. Audio Mixing or Selection

TL/H/7383-96

10.9 A LOW FREQUENCY MIXER

The diode which exists at the (+) input can be used for non-linear signal processing. An example of this is a mixer which allows two input frequencies to produce a sum and difference frequency (in addition to other high frequency components). Using the amplifier of the LM3900, gain and filtering can also be accomplished with the same circuit in addition to the high input impedance and low output impedance advantages. The schematic of *Figure 88* shows a mixer with a gain of 10 and a low pass single pole filter (1M and 150 pF feedback elements) with a corner frequency of 1 kHz. With one signal larger in amplitude, to serve as the local oscillator input (V_1), the transconductance of the input diode is gated at this rate (f_1). A small signal (V_2) can now be added at the second input and the difference frequency is filtered from the composite resulting waveform and is made available at the output. Relatively high frequencies can be applied at the inputs as long as the desired difference frequency is within the bandwidth capabilities of the amplifier and the RC low pass filter.



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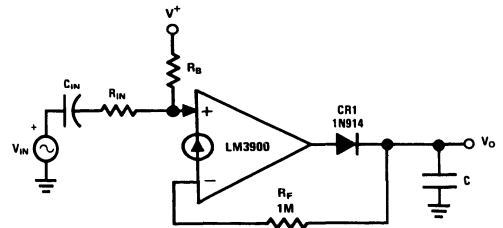
FIGURE 88. A Low Frequency Mixer

10.10 A PEAK DETECTOR

A peak detector is often used to rapidly charge a capacitor to the peak value of an input waveform. The voltage drop across the rectifying diode is placed within the feedback loop of an op amp to prevent voltage losses and temperature drifts in the output voltage. The LM3900 can be used as a peak detector as shown in *Figure 89*. The feedback resistor, R_f , is kept small (1 M Ω) so that the 30 nA base current will cause only a +30 mV error in V_O . This feedback resis-

tor is constantly loading C in addition to the current drawn by the circuitry which samples V_O . These loading effects must be considered when selecting a value for C.

The biasing resistor, R_B , allows a minimum DC voltage to exist across the capacitor and the input resistor, R_{IN} , can be selected to provide gain to the input signal.



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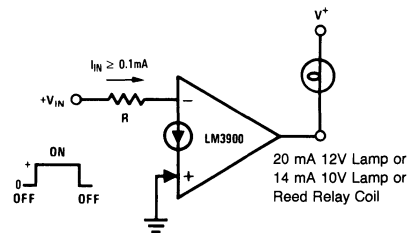
FIGURE 89. A Peak Detector

10.11 POWER CIRCUITS

The amplifier of the LM3900 will source a maximum current of approximately 10 mA and will sink maximum currents of approximately 80 mA (if overdriven at the (-) input). If the output is driven to a saturated state to reduce device dissipation, some interesting power circuits can be realized. These maximum values of current are typical values for the unit operating at 25°C and therefore have to be de-rated for reliable operation. For fully switched operation, amplifiers can be paralleled to increase current capability.

10.11.1 LAMP AND/OR RELAY DRIVERS (≤ 30 mA)

Low power lamps and relays (as reed relays) can be directly controlled by making use of the larger value of sink current than source current. A schematic is shown in *Figure 90* where the input resistor, R, is selected such that V_{IN} supplies at least 0.1 mA of input current.



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FIGURE 90. Sinking 20 to 30 mA Loads

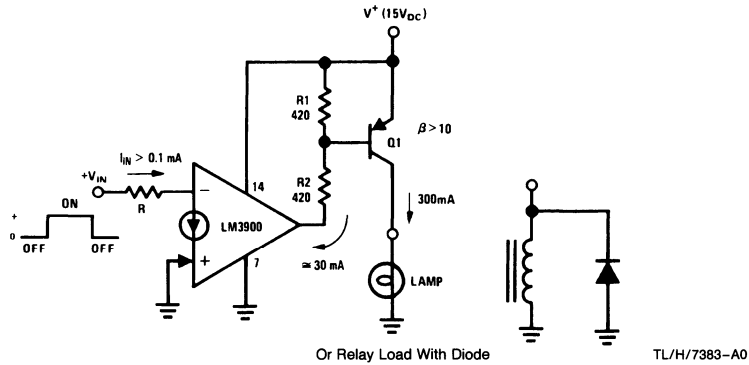


FIGURE 91. Boosting to 300 mA Loads

10.11.2 LAMP AND/OR RELAY DRIVERS (≤ 300 mA)

To increase the power capability, an external transistor can be added as shown in *Figure 91*. The resistors R_1 and R_2 hold Q_1 OFF when the output of the LM3900 is high. The resistor, R_2 , limits the base drive when Q_1 goes ON. It is required that pin 14 tie to the same power supply as the emitter of Q_1 to guarantee that Q_1 can be held OFF. If an inductive load is used, such as a relay coil, a backswing diode should be added to prevent large inductive voltage kicks during the switching interval, ON to OFF.

10.11.3 POSITIVE FEEDBACK OSCILLATORS

If the LM3900 is biased into the active region and a resonant circuit is connected from the output to the (+) input, a positive feedback oscillator results. A driver for a piezoelectric transducer (a warning type of noise maker) is shown in *Figure 92*. The resistors R_1 and R_2 bias the output voltage at $V^+ / 2$ and keep the amplifier active. Large currents can be entered into the (+) input and negative currents (or currents out of this terminal) are provided by the epi-substrate diode of the IC fabrication.

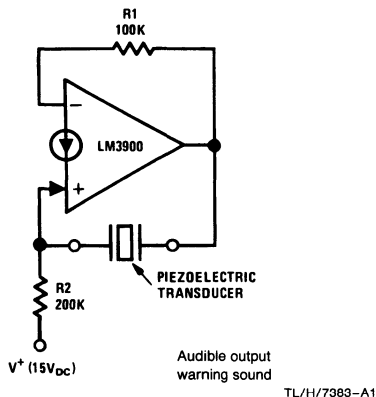


FIGURE 92. Positive Feedback Power Oscillators

When one of the amplifiers is operated in this large negative input current mode, the other amplifiers will be disturbed due to interaction. Multiple sounds may be generated as a result of using two or more transducers in various combinations, but this has not been investigated. Other two-terminal RC, RLC or piezoelectric resonators can be connected in this circuit to produce an oscillator.

10.12 HIGH VOLTAGE OPERATION

The amplifiers of the LM3900 can drive an external high voltage NPN transistor to provide a larger output voltage swing (as for an electrostatic CRT deflection system) or to operate off of an existing high voltage power supply (as the $+98 V_{DC}$ rectified line). Examples of both types of circuits are presented in this section.

10.12.1 A HIGH VOLTAGE INVERTING AMPLIFIER

An inverting amplifier with an output voltage swing from essentially $0 V_{DC}$ to $+300 V_{DC}$ is shown in *Figure 93*. The transistor, Q_1 , must be a high breakdown device as it will have the full HV supply across it. The biasing resistor R_3 is used to center the transfer characteristic and the gain is the ratio of R_2 to R_1 . The load resistor, R_L , can be increased, if desired, to reduce the HV current drain.

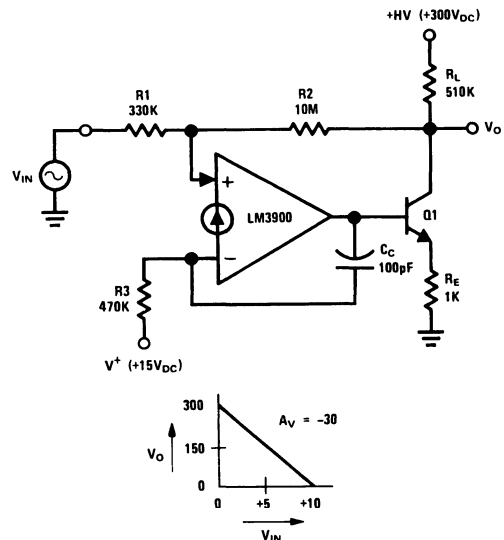


FIGURE 93. A High Voltage Inverting Amplifier

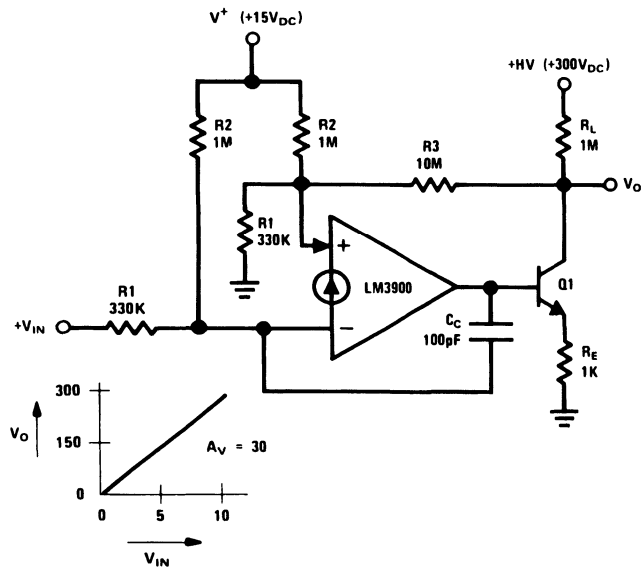


FIGURE 94. A High Voltage Non-Inverting Amplifier

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10.12.2 A HIGH VOLTAGE NON-INVERTING AMPLIFIER

A high voltage non-inverting amplifier is shown in Figure 94. Common-mode biasing resistors (R_2) are used to allow V_{IN} to go to 0 V_{DC} . The output voltage, V_O , will not actually go to zero due to R_E , but should go to approximately 0.3 V_{DC} . Again, the gain is 30 and a range of the input voltage of from 0 to +10 V_{DC} will cause the output voltage to range from approximately 0 to +300 V_{DC} .

10.12.3 A LINE OPERATED AUDIO AMPLIFIER

An audio amplifier which operates off a +98 V_{DC} power supply (the rectified line voltage) is often used in consumer products. The external high voltage transistor, Q_1 of Figure 95, is biased and controlled by the LM3900. The magnitude of the DC biasing voltage which appears across the emitter resistor of Q_1 is controlled by the resistor which is placed from the (-) input to ground.

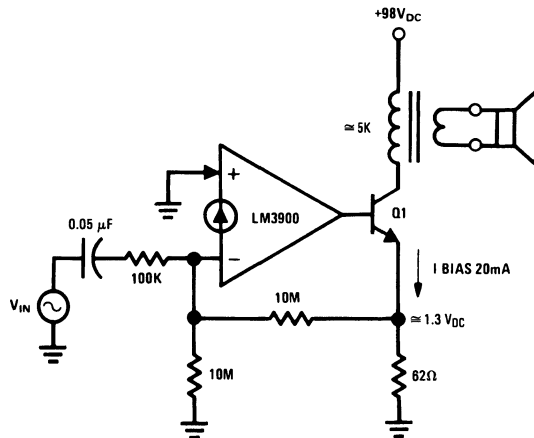


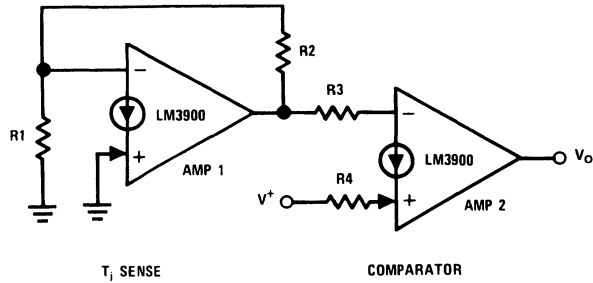
FIGURE 95. A Line Operated Audio Amplifier

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10.13 TEMPERATURE SENSING

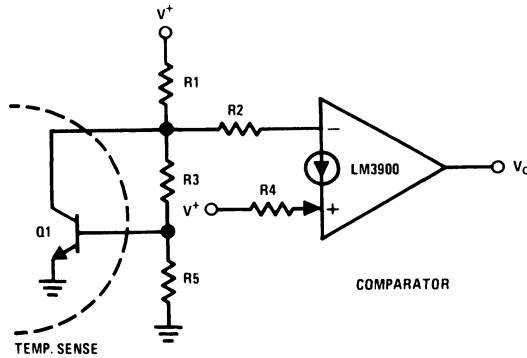
The LM3900 can be used to monitor the junction temperature of the monolithic chip as shown in *Figure 96(a)*. Amp. 1 will generate an output voltage which can be designed to undergo a large negative temperature change by design of R_1 and R_2 . The second amplifier compares this temperature dependent voltage with the power supply voltage and goes high at a designed maximum T_j of the IC.

For remote sensing, an NPN transistor, Q_1 of *Figure 96(b)*, is connected as an N V_{BE} generator (with R_3 and R_5) and biased via R_1 from the power supply voltage, V^+ . The LM3900 again compares this temperature dependent voltage with the supply voltage and can be designed to have V_O go high at a maximum temperature of the remote temperature sensor, Q_1 .



(a) IC T_j Monitor

TL/H/7383-A6



(b) Remote Temperature Sense

TL/H/7383-A7

FIGURE 96. Temperature Sensing

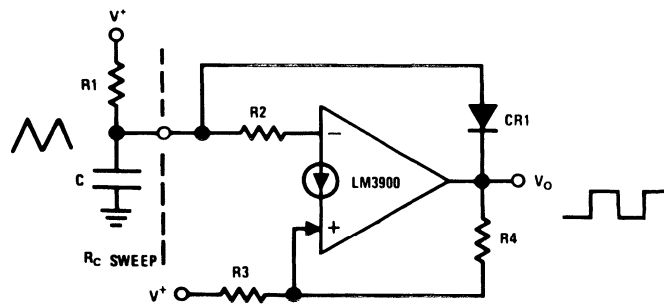


FIGURE 97. A "Programmable Unijunction"

TL/H/7383-A8

10.14 A "PROGRAMMABLE UNIUNCTION"

If a diode is added to the Schmitt Trigger, a "programmable unijunction" function can be obtained as shown in *Figure 97*. For a low input voltage, the output voltage of the LM3900 is high and CR1 is OFF. When the input voltage rises to the high trip voltage, the output falls to essentially 0V and CR1 goes ON to discharge the input capacitor, C.

The low trip voltage must be larger than approximately 1V to guarantee that the forward drop of CR1 added to the output voltage of the LM3900 will be less than the low trip voltage. The discharge current can be increased by using smaller values for R_2 to provide pull-down currents larger than the 1.3 mA bias current source. The trip voltages of the Schmitt Trigger are designed as shown in section 9.7.

10.15 ADDING A DIFFERENTIAL INPUT STAGE

A differential amplifier can be added to the input of the LM3900 as shown in *Figure 98*. This will increase the gain and reduce the offset voltage. Frequency compensation can be added as shown. The BV_{EBO} limit of the input transistors must not be exceeded during a large differential input condition, or diodes and input limiting resistors should be added to restrict the input voltage which is applied to the bases of Q_1 and Q_2 to $\pm V_D$.

The input common-mode voltage range does not go exactly to ground as a few tenths of a volt are needed to guarantee that Q_1 or Q_2 will not saturate and cause a phase change (and a resulting latch-up). The input currents will be small, but could be reduced further, if desired, by using FETS for Q_1 and Q_2 . This circuit can also be operated off of ± 15 V_{DC} supplies.

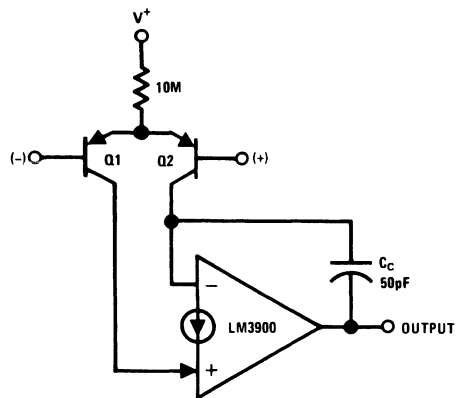


FIGURE 98. Adding a Differential Input Stage

TL/H/7383-A9

LM139/LM239/LM339

A Quad of Independently Functioning Comparators

National Semiconductor
Application Note 74
T. M. Frederiksen



INTRODUCTION

The LM139/LM239/LM339 family of devices is a monolithic quad of independently functioning comparators designed to meet the needs for a medium speed, TTL compatible comparator for industrial applications. Since no antisaturation clamps are used on the output such as a Baker clamp or other active circuitry, the output leakage current in the OFF state is typically 0.5 nA. This makes the device ideal for system applications where it is desired to switch a node to ground while leaving it totally unaffected in the OFF state.

Other features include single supply, low voltage operation with an input common mode range from ground up to approximately one volt below V_{CC} . The output is an uncommitted collector so it may be used with a pull-up resistor and a separate output supply to give switching levels from any voltage up to 36V down to a $V_{CE\ SAT}$ above ground (approx. 100 mV), sinking currents up to 15 mA. In addition it may be used as a single pole switch to ground, leaving the switched node unaffected while in the OFF state. Power dissipation with all four comparators in the OFF state is typically 4 mW from a single 5V supply (1 mW/comparator).

CIRCUIT DESCRIPTION

Figure 1 shows the basic input stage of one of the four comparators of the LM139. Transistors Q_1 through Q_4 make up a PNP Darlington differential input stage with Q_5 and Q_6 serving to give single-ended output from differential input with no loss in gain. Any differential input at Q_1 and Q_4 will be amplified causing Q_6 to switch OFF or ON depending

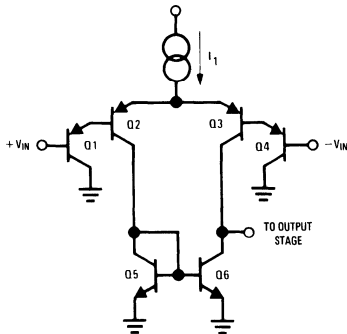


FIGURE 1. Basic LM139 Input Stage

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on input signal polarity. It can easily be seen that operation with an input common mode voltage of ground is possible. With both inputs at ground potential, the emitters of Q_1 and Q_4 will be at one V_{BE} above ground and the emitters of Q_2 and Q_3 at 2 V_{BE} . For switching action the base of Q_5 and Q_6 need only go to one V_{BE} above ground and since Q_2 and Q_3 can operate with zero volts collector to base, enough voltage is present at a zero volt common mode input to insure comparator action. The bases should not be taken more than several hundred millivolts below ground, however, to prevent forward biasing a substrate diode which would stop all comparator action and possibly damage the device, if very large input currents were provided.

Figure 2 shows the comparator with the output stage added. Additional voltage gain is taken through Q_7 and Q_8 with the collector of Q_8 left open to offer a wide variety of possible applications. The addition of a large pull-up resistor from the collector of Q_8 to either $+V_{CC}$ or any other supply up to 36V both increases the LM139 gain and makes possible output switching levels to match practically any application. Several outputs may be tied together to provide an ORING function or the pull-up resistor may be omitted entirely with the comparator then serving as a SPST switch to ground.

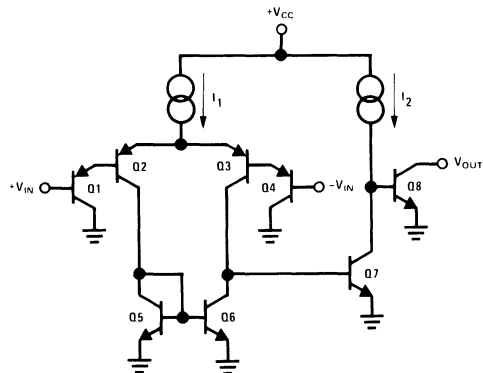
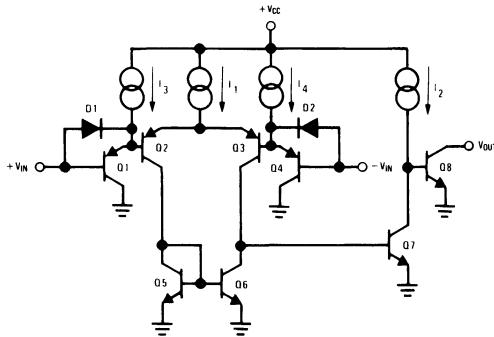


FIGURE 2. Basic LM139 Comparator

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Output transistor Q_8 will sink up to 15 mA before the output ON voltage rises above several hundred millivolts. The output current sink capability may be boosted by the addition of a discrete transistor at the output.

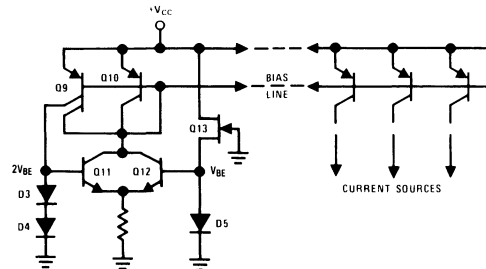
The complete circuit for one comparator of the LM139 is shown in *Figure 3*. Current sources I_3 and I_4 are added to help charge any parasitic capacitance at the emitters of Q_1 and Q_4 to improve the slew rate of the input stage. Diodes D_1 and D_2 are added to speed up the voltage swing at the emitters of Q_1 and Q_2 for large input voltage swings.



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FIGURE 3. Complete LM139 Comparator Circuit

Biasing for current sources I_1 through I_4 is shown in *Figure 4*. When power is first applied to the circuit, current flows through the JFET Q_{13} to bias up diode D_5 . This biases transistor Q_{12} which turns ON transistors Q_9 and Q_{10} by allowing a path to ground for their base and collector currents.



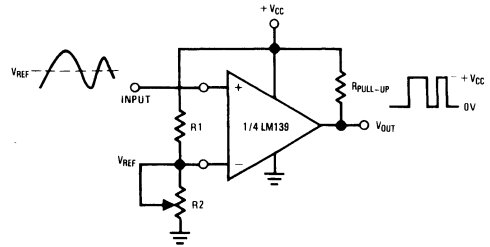
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FIGURE 4. Current Source Biasing Circuit

Current from the left hand collector of Q_9 flows through diodes D_3 and D_4 bringing up the base of Q_{11} to $2V_{BE}$ above ground and the emitters of Q_{11} and Q_{12} to one V_{BE} . Q_{12} will then turn OFF because its base emitter voltage goes to zero. This is the desired action because Q_9 and Q_{10} are biased ON through Q_{11} , D_3 and D_4 so Q_{12} is no longer needed. The "bias line" is now sitting at a V_{BE} below $+V_{CC}$ which is the voltage needed to bias the remaining current sources in the LM139 which will have a constant bias regardless of $+V_{CC}$ fluctuations. The upper input common mode voltage is V_{CC} minus the saturation voltage of the current sources (approximately 100 mV) minus the $2V_{BE}$ of the input devices Q_1 and Q_2 (or Q_3 and Q_4).

COMPARATOR CIRCUITS

Figure 5 shows a basic comparator circuit for converting low level analog signals to a high level digital output. The output pull-up resistor should be chosen high enough so as to avoid excessive power dissipation yet low enough to supply enough drive to switch whatever load circuitry is used on the comparator output. Resistors R_1 and R_2 are used to set the input threshold trip voltage (V_{REF}) at any value desired within the input common mode range of the comparator.

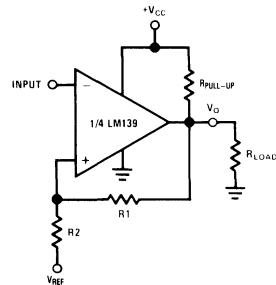


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FIGURE 5. Basic Comparator Circuit

COMPARATORS WITH HYSTERESIS

The circuit shown in *Figure 5* suffers from one basic drawback in that if the input signal is a slowly varying low level signal, the comparator may be forced to stay within its linear region between the output high and low states for an undesirable length of time. If this happens, it runs the risk of oscillating since it is basically an uncompensated, high gain op amp. To prevent this, a small amount of positive feedback or hysteresis is added around the comparator. *Figure 6*



TL/H/7385-6

FIGURE 6. Comparator with Positive Feedback to Improve Switching Time

shows a comparator with a small amount of positive feedback. In order to insure proper comparator action, the components should be chosen as follows:

$$R_{PULL-UP} < R_{LOAD} \text{ and}$$

$$R_1 > R_{PULL-UP}$$

This will insure that the comparator will always switch fully up to $+V_{CC}$ and not be pulled down by the load or feedback. The amount of feedback is chosen arbitrarily to insure proper switching with the particular type of input signal

used. If the output swing is 5V, for example, and it is desired to feedback 1% or 50 mV, then $R_1 \approx 100 R_2$. To describe circuit operation, assume that the inverting input goes above the reference input ($V_{IN} > V_{REF}$). This will drive the output, V_O , towards ground which in turn pulls V_{REF} down through R_1 . Since V_{REF} is actually the noninverting input to the comparator, it too will drive the output towards ground insuring the fastest possible switching time regardless of how slow the input moves. If the input then travels down to V_{REF} , the same procedure will occur only in the opposite direction insuring that the output will be driven hard towards $+V_{CC}$.

Putting hysteresis in the feedback loop of the comparator has far more use, however, than simply as an oscillation suppressor. It can be made to function as a Schmitt trigger with presettable trigger points. A typical circuit is shown in Figure 7. Again, the hysteresis is achieved by shifting the reference voltage at the positive input when the output voltage V_O changes state. This network requires only three resistors and is referenced to the positive supply $+V_{CC}$ of the comparator. This can be modeled as a resistive divider, R_1 and R_2 , between $+V_{CC}$ and ground with the third resistor, R_3 , alternately connected to $+V_{CC}$ or ground, paralleling either R_1 or R_2 . To analyze this circuit, assume that the input voltage, V_{IN} , at the inverting input is less than V_A . With $V_{IN} \leq V_A$ the output will be high ($V_O = +V_{CC}$). The upper input trip voltage, V_{A1} , is defined by:

$$V_{A1} = \frac{+V_{CC} R_2}{(R_1 \parallel R_3) + R_2}$$

or

$$V_{A1} = \frac{+V_{CC} R_2 (R_1 + R_3)}{R_1 R_2 + R_1 R_3 + R_2 R_3} \quad (1)$$

When the input voltage V_{IN} , rises above the reference voltage ($V_{IN} > V_{A1}$), voltage, V_O , will go low ($V_O = \text{GND}$). The lower input trip voltage, V_{A2} , is now defined by:

$$V_{A2} = \frac{+V_{CC} R_2 \parallel R_3}{R_1 + R_2 \parallel R_3}$$

or

$$V_{A2} = \frac{+V_{CC} R_2 R_3}{R_1 R_2 + R_1 R_3 + R_2 R_3} \quad (2)$$

When the input voltage, V_{IN} , decreases to V_{A2} or lower, the output will again switch high. The total hysteresis, ΔV_A , provided by this network is defined by:

$$\Delta V_A = V_{A1} - V_{A2}$$

or, subtracting equation 2 from equation 1

$$\Delta V_A \Delta \frac{+V_{CC} R_1 R_2}{R_1 R_2 + R_1 R_3 + R_2 R_3} \quad (3)$$

To insure that V_O will swing between $+V_{CC}$ and ground, choose:

$$R_{\text{PULL-UP}} < R_{\text{LOAD}} \text{ and} \quad (4)$$

$$R_3 > R_{\text{PULL-UP}} \quad (5)$$

Heavier loading on $R_{\text{PULL-UP}}$ (i.e. smaller values of R_3 or R_{LOAD}) simply reduces the value of the maximum output voltage thereby reducing the amount of hysteresis by lowering the value of V_{A1} . For simplicity, we have assumed in the above equations that V_O high switches all the way up to $+V_{CC}$.

To find the resistor values needed for a given set of trip points, we first divide equation (3) by equation (2). This gives us the ratio:

$$\frac{\Delta V_A}{V_{A2}} = \frac{1 + \frac{R_1}{R_3} + \frac{R_1}{R_2}}{1 + \frac{R_3}{R_2} + \frac{R_3}{R_1}} \quad (6)$$

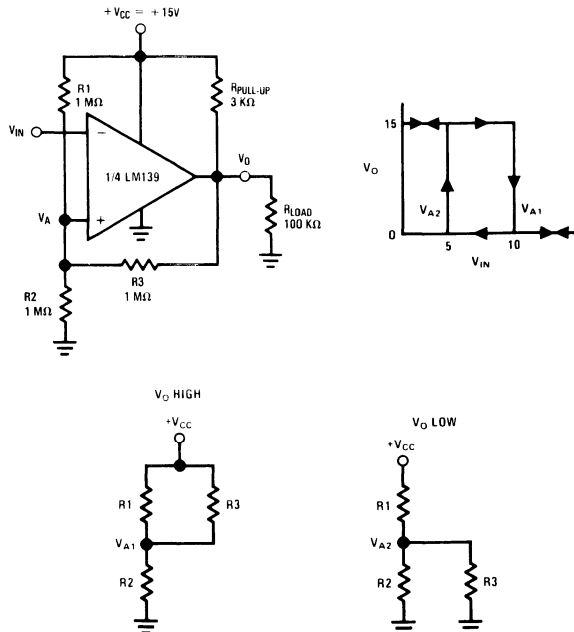


FIGURE 7. Inverting Comparator with Hysteresis

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If we let $R_1 = n R_3$, equation (6) becomes:

$$\frac{\Delta V_A}{V_{A2}} = n \quad (7)$$

We can then obtain an expression for R_2 from equation (1) which gives

$$R_2 = \frac{R_1 \parallel R_3}{\frac{+V_{CC}}{V_{A1}} - 1} \quad (8)$$

The following design example is offered:

$$\begin{aligned} \text{Given: } V^+ &= +15\text{V} \\ R_{\text{LOAD}} &= 100 \text{ k}\Omega \\ V_{A1} &= +10\text{V} \\ V_{A2} &= +5\text{V} \end{aligned}$$

To find: $R_1, R_2, R_3, R_{\text{PULL-UP}}$

Solution:

$$\begin{aligned} \text{From equation (4)} \quad R_{\text{PULL-UP}} &< R_{\text{LOAD}} \\ R_{\text{PULL-UP}} &< 100 \text{ k}\Omega \\ \text{so let} \quad R_{\text{PULL-UP}} &= 3 \text{ k}\Omega \end{aligned}$$

$$\begin{aligned} \text{From equation (5)} \quad R_3 &> R_{\text{LOAD}} \\ R_3 &> 100 \text{ k}\Omega \end{aligned}$$

$$\text{so let} \quad R_3 = 1 \text{ M}\Omega$$

$$\text{From equation (7)} \quad n = \frac{\Delta V_A}{V_{A2}} = \frac{10 - 5}{5} = 1$$

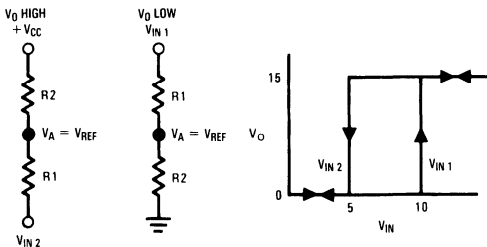
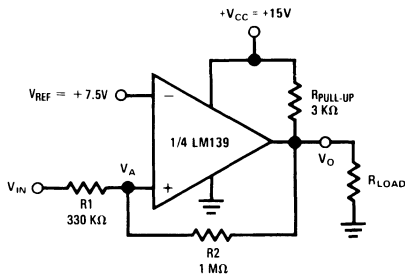
$$\text{and since} \quad R_1 = n R_3$$

$$\text{this gives} \quad R_1 = 1 R_3 = 1 \text{ M}\Omega$$

$$\text{From equation (8)} \quad R_2 = \frac{500 \text{ k}\Omega}{\frac{15}{10} - 1} = 1 \text{ M}\Omega$$

These are the values shown in Figure 7.

The circuit shown in Figure 8 is a non-inverting comparator with hysteresis which is obtained with only two resistors, R_1



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FIGURE 8. Non-Inverting Comparator with Hysteresis

and R_2 . In contrast to the first method, however, this circuit requires a separate reference voltage at the negative input. The trip voltage, V_A , at the positive input is shifted about V_{REF} as V_O changes between $+V_{\text{CC}}$ and ground.

Again for analysis, assume that the input voltage, V_{IN} , is low so that the output, V_O , is also low ($V_O = \text{GND}$). For the output to switch, V_{IN} must rise up to $V_{\text{IN}1}$ where $V_{\text{IN}1}$ is given by:

$$V_{\text{IN}1} = \frac{V_{\text{REF}}(R_1 + R_2)}{R_2} \quad (9)$$

As soon as V_O switches to $+V_{\text{CC}}$, V_A will step to a value greater than V_{REF} which is given by:

$$V_A = V_{\text{IN}} + \frac{(V_{\text{CC}} - V_{\text{IN}1})R_1}{R_1 + R_2} \quad (10)$$

To make the comparator switch back to its low state ($V_O = \text{GND}$) V_{IN} must go below V_{REF} before V_A will again equal V_{REF} . This lower trip point is now given by:

$$V_{\text{IN}2} = \frac{V_{\text{REF}}(R_1 + R_2) - V_{\text{CC}}R_1}{R_2} \quad (11)$$

The hysteresis for this circuit, ΔV_{IN} , is the difference between $V_{\text{IN}1}$ and $V_{\text{IN}2}$ and is given by:

$$\begin{aligned} \Delta V_{\text{IN}} &= V_{\text{IN}1} - V_{\text{IN}2} = \\ &= \frac{V_{\text{REF}}(R_1 + R_2)}{R_2} - \frac{V_{\text{REF}}(R_1 + R_2) - V_{\text{CC}}R_1}{R_2} \end{aligned}$$

or

$$\Delta V_{\text{IN}} = \frac{V_{\text{CC}}R_1}{R_2} \quad (12)$$

As a design example consider the following:

$$\begin{aligned} \text{Given: } R_{\text{LOAD}} &= 100 \text{ k}\Omega \\ V_{\text{IN}1} &= 10\text{V} \\ V_{\text{IN}2} &= 5\text{V} \\ +V_{\text{CC}} &= 15\text{V} \end{aligned}$$

To find: V_{REF}, R_1, R_2 and R_3

Solution:

Again choose $R_{\text{PULL-UP}} < R_{\text{LOAD}}$ to minimize loading, so let

$$R_{\text{PULL-UP}} = 3 \text{ k}\Omega$$

$$\text{From equation (12)} \quad \frac{R_1}{R_2} = \frac{\Delta V_{\text{IN}}}{V_{\text{CC}}}$$

$$\frac{R_1}{R_2} = \frac{10 - 5}{15} = \frac{1}{3}$$

$$R_1 = \frac{R_2}{3}$$

$$\text{From equation (9)} \quad V_{\text{REF}} = \frac{10}{1 + \frac{R_1}{R_2}}$$

$$V_{\text{REF}} = \frac{V_{\text{IN}}}{1 + \frac{1}{3}} = 7.5\text{V}$$

To minimize output loading choose

$$R_2 > R_{\text{PULL-UP}}$$

or

$$R_2 > 3 \text{ k}\Omega$$

so let

$$R_2 = 1 \text{ M}\Omega$$

The value of R_1 is now obtained from equation (12)

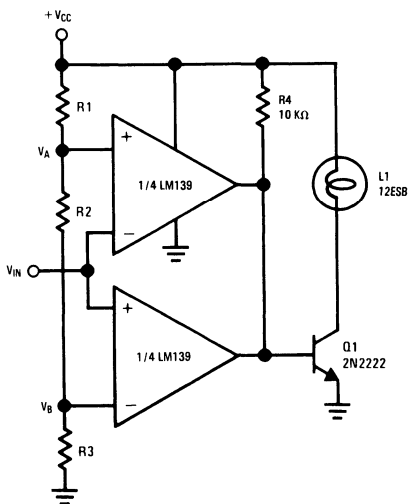
$$R_1 = \frac{R_2}{3}$$

$$R_1 = \frac{1 \text{ M}\Omega}{3} \cong 330 \text{ k}\Omega$$

These are the values shown in *Figure 8*.

LIMIT COMPARATOR WITH LAMP DRIVER

The limit comparator shown in *Figure 9* provides a range of input voltages between which the output devices of both LM139 comparators will be OFF.



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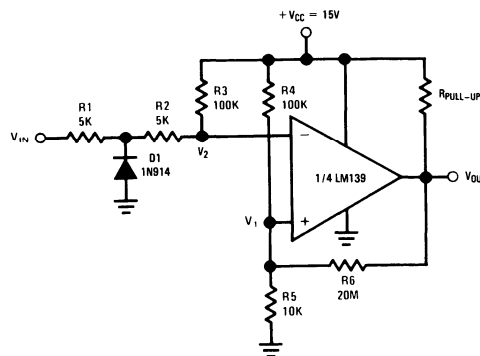
FIGURE 9. Limit Comparator with Lamp Driver

This will allow base current for Q_1 to flow through pull-up resistor R_4 , turning ON Q_1 which lights the lamp. If the input voltage, V_{IN} , changes to a value greater than V_A or less than V_B , one of the comparators will switch ON, shorting the base of Q_1 to ground, causing the lamp to go OFF. If a PNP transistor is substituted for Q_1 (with emitter tied to $+V_{CC}$) the lamp will light when the input is above V_A or below V_B . V_A and V_B are arbitrarily set by varying resistors R_1 , R_2 and R_3 .

ZERO CROSSING DETECTOR

The LM139 can be used to symmetrically square up a sine wave centered around zero volts by incorporating a small amount of positive feedback to improve switching times and centering the input threshold at ground (see *Figure 10*). Voltage divider R_4 and R_5 establishes a reference voltage, V_1 , at the positive input. By making the series resistance, R_1 plus R_2 equal to R_5 , the switching condition, $V_1 = V_2$, will be satisfied when $V_{IN} = 0$. The positive feedback resistor,

R_6 , is made very large with respect to R_5 ($R_6 = 2000 R_5$). The resultant hysteresis established by this network is very small ($\Delta V_1 < 10 \text{ mV}$) but it is sufficient to insure rapid output voltage transitions. Diode D_1 is used to insure that



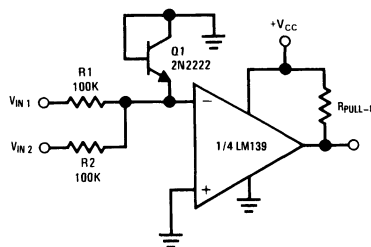
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FIGURE 10. Zero Crossing Detector

the inverting input terminal of the comparator never goes below approximately -100 mV . As the input terminal goes negative, D_1 will forward bias, clamping the node between R_1 and R_2 to approximately -700 mV . This sets up a voltage divider with R_2 and R_3 preventing V_2 from going below ground. The maximum negative input overdrive is limited by the current handling ability of D_1 .

COMPARING THE MAGNITUDE OF VOLTAGES OF OPPOSITE POLARITY

The comparator circuit shown in *Figure 11* compares the magnitude of two voltages, $V_{IN 1}$ and $V_{IN 2}$ which have opposite polarities. The resultant input voltage at the minus input terminal to the comparator, V_A , is a function of the voltage divider from $V_{IN 1}$ and $V_{IN 2}$ and the values of R_1 and R_2 . Diode connected transistor Q_1 provides protection



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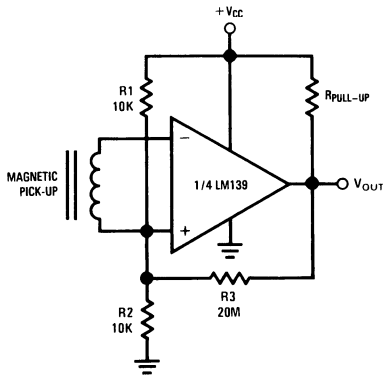
FIGURE 11. Comparing the Magnitude of Voltages of Opposite Polarity

for the minus input terminal by clamping it at several hundred millivolts below ground. A 2N2222 was chosen over a 1N914 diode because of its lower diode voltage. If desired, a small amount of hysteresis may be added using the techniques described previously. Correct magnitude comparison can be seen as follows: Let $V_{IN 1}$ be the input for the positive polarity input voltage and $V_{IN 2}$ the input for the negative polarity. If the magnitude of $V_{IN 1}$ is greater than that

of V_{IN2} the output will go low ($V_{OUT} = \text{GND}$). If the magnitude of V_{IN1} is less than that of V_{IN2} , however, the output will go high ($V_{OUT} = V_{CC}$).

MAGNETIC TRANSDUCER AMPLIFIER

A circuit that will detect the zero crossings in the output of a magnetic transducer is shown in *Figure 12*. Resistor divider, R_1 and R_2 , biases the positive input at $+V_{CC}/2$, which is well within the common mode operating range. The minus



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FIGURE 12. Magnetic Transducer Amplifier

input is biased through the magnetic transducer. This allows large signal swings to be handled without exceeding the input voltage limits. A symmetrical square wave output is insured through the positive feedback resistor R_3 . Resistors R_1 and R_2 can be used to set the DC bias voltage at the positive input at any desired voltage within the input common mode voltage range of the comparator.

OSCILLATORS USING THE LM139

The LM139 lends itself well to oscillator applications for frequencies below several megacycles. *Figure 13* shows a symmetrical square wave generator using a minimum of components. The output frequency is set by the RC time

constant of R_4 and C_1 and the total hysteresis of the loop is set by R_1 , R_2 and R_3 . The maximum frequency is limited only by the large signal propagation delay of the comparator in addition to any capacitive loading at the output which would degrade the output slew rate.

To analyze this circuit assume that the output is initially high. For this to be true, the voltage at the negative input must be less than the voltage at the positive input. Therefore, capacitor C_1 is discharged. The voltage at the positive input, V_{A1} , will then be given by:

$$V_{A1} = \frac{+V_{CC} R_2}{R_2 + (R_1 \parallel R_3)} \quad (13)$$

where if $R_1 = R_2 = R_3$

$$\text{then } V_{A1} = \frac{2 V_{CC}}{3} \quad (14)$$

Capacitor C_1 will charge up through R_4 so that when it has charged up to a value equal to V_{A1} , the comparator output will switch. With the output $V_O = \text{GND}$, the value of V_A is reduced by the hysteresis network to a value given by:

$$V_{A2} = \frac{+V_{CC}}{3} \quad (15)$$

using the same resistor values as before. Capacitor C_1 must now discharge through R_4 towards ground. The output will return to its high state ($V_O = +V_{CC}$) when the voltage across the capacitor has discharged to a value equal to V_{A2} . For the circuit shown, the period for one cycle of oscillation will be twice the time it takes for a single RC circuit to charge up to one half of its final value. The period can be calculated from:

$$V_1 = V_{MAX} e^{-t_1/RC} \quad (16)$$

where

$$V_{MAX} = \frac{2 V_{CC}}{3} \quad (17)$$

and

$$V_1 = \frac{V_{MAX}}{2} = \frac{V_{CC}}{3} \quad (18)$$

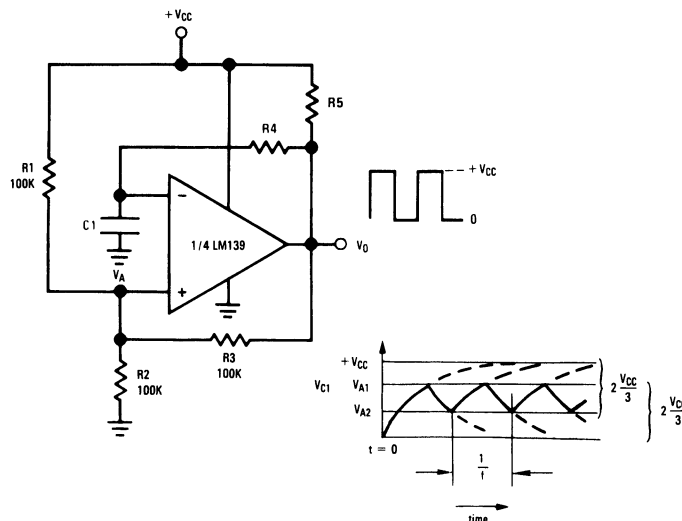


FIGURE 13. Square Wave Generator

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One period will be given by:

$$\frac{1}{\text{freq.}} = 2t_1 \quad (19)$$

or calculating the exponential gives

$$\frac{1}{\text{freq.}} = 2 (0.694) R_4 C_1 \quad (20)$$

Resistors R_3 and R_4 must be at least 10 times larger than R_5 to insure that V_O will go all the way up to $+V_{CC}$ in the high state. The frequency stability of this circuit should strictly be a function of the external components.

PULSE GENERATOR WITH VARIABLE DUTY CYCLE

The basic square wave generator of *Figure 13* can be modified to obtain an adjustable duty cycle pulse generator, as shown in *Figure 14*, by providing a separate charge and discharge path for capacitor C_1 . One path, through R_4 and D_1 will charge the capacitor and set the pulse width (t_1). The other path, R_5 and D_2 , will discharge the capacitor and set the time between pulses (t_2). By varying resistor R_5 , the time between pulses of the generator can be changed with-

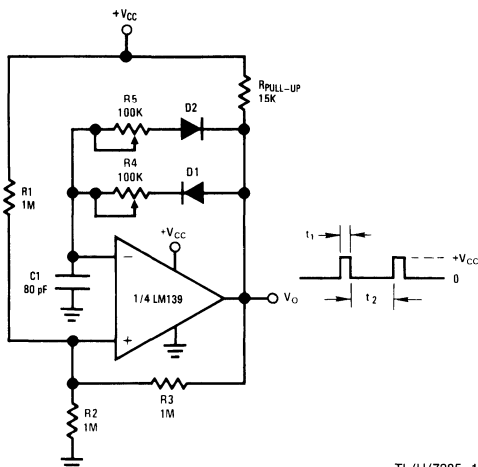


FIGURE 14. Pulse Generator with Variable Duty Cycle

out changing the pulse width. Similarly, by varying R_4 , the pulse width will be altered without affecting the time between pulses. Both controls will change the frequency of the generator, however. With the values given in *Figure 14*, the pulse width and time between pulses can be found from:

$$V_1 = V_{MAX} (1 - e^{-t_1/R_4 C_1}) \text{ risetime} \quad (21a)$$

$$V_1 = V_{MAX} e^{-t_2/R_5 C_1} \text{ falltime} \quad (21b)$$

where

$$V_{MAX} = \frac{2 V_{CC}}{3} \quad (22)$$

and

$$V_1 = \frac{V_{MAX}}{2} = \frac{V_{CC}}{3} \quad (23)$$

which gives

$$\frac{1}{2} = e^{-t_1/R_4 C_1} \quad (24)$$

t_2 is then given by:

$$\frac{1}{2} = e^{-t_2/R_5 C_1} \quad (25)$$

These terms will have a slight error due to the fact that V_{MAX} is not exactly equal to $\frac{2}{3} V_{CC}$ but is actually reduced by the diode drop to:

$$V_{MAX} = \frac{2}{3} (V_{CC} - V_{BE}) \quad (26)$$

therefore

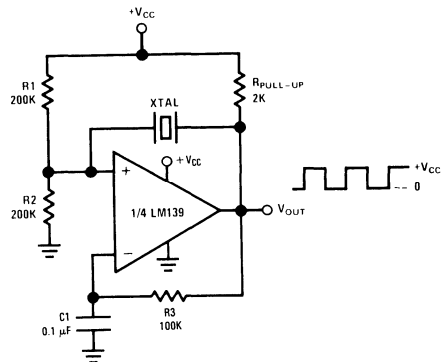
$$\frac{1}{2(1 - V_{BE})} = e^{-t_1/R_4 C_1} \quad (27)$$

and

$$\frac{1}{2(1 - V_{BE})} = e^{-t_2/R_5 C_1} \quad (28)$$

CRYSTAL CONTROLLED OSCILLATOR

A simple yet very stable oscillator can be obtained by using a quartz crystal resonator as the feedback element. *Figure 15* gives a typical circuit diagram of this. This value of R_1



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FIGURE 15. Crystal Controlled Oscillator

and R_2 are equal so that the comparator will switch symmetrically about $+V_{CC}/2$. The RC time constant of R_3 and C_1 is set to be several times greater than the period of the oscillating frequency, insuring a 50% duty cycle by maintaining a DC voltage at the inverting input equal to the absolute average of the output waveform.

When specifying the crystal, be sure to order series resonant along with the desired temperature coefficient and load capacitance to be used.

MOS CLOCK DRIVER

The LM139 can be used to provide the oscillator and clock delay timing for a two phase MOS clock driver (see *Figure 16*). The oscillator is a standard comparator square wave generator similar to the one shown in *Figure 13*. Two other comparators of the LM139 are used to establish the desired phasing between the two outputs to the clock driver. A more detailed explanation of the delay circuit is given in the section under "Digital and Switching Circuits."

WIDE RANGE VCO

A simple yet very stable voltage controlled oscillator using a minimum of external components can be realized using three comparators of the LM139. The schematic is shown in *Figure 17a*. Comparator 1 is used closed loop as an integrator (for further discussion of closed loop operation see section on Operational Amplifiers) with comparator 2 used as a triangle to square wave converter and comparator 3 as the switch driving the integrator. To analyze the circuit, assume

that comparator 2 is its high state ($V_{SQ} = +V_{CC}$) which drives comparator 3 to its high state also. The output device of comparator 3 will be OFF which prevents any current from flowing through R_2 to ground. With a control voltage, V_C , at the input to comparator 1, a current I_1 will flow through R_1 and begin discharging capacitor C_1 , at a linear rate. This discharge current is given by:

$$I_1 = \frac{V_C}{2R_1} \quad (29)$$

and the discharge time is given by:

$$I_1 = C_1 \frac{\Delta V}{\Delta t} \quad (30)$$

ΔV will be the maximum peak change in the voltage across capacitor C_1 which will be set by the switch points of com-

parator 2. These trip points can be changed by simply altering the ratio of R_F to R_S , thereby increasing or decreasing the amount of hysteresis around comparator 2. With $R_F = 100 \text{ k}\Omega$ and $R_S = 5 \text{ k}\Omega$, the amount of hysteresis is approximately $\pm 5\%$ which will give switch points of $+V_{CC}/2 \pm 750 \text{ mV}$ from a 30V supply. (See "Comparators with Hysteresis").

As capacitor C_1 discharges, the output voltage of comparator 1 will decrease until it reaches the lower trip point of comparator 2, which will then force the output of comparator 2 to go to its low state ($V_{SQ} = \text{GND}$).

This in turn causes comparator 3 to go to its low state where its output device will be in saturation. A current I_2 can now

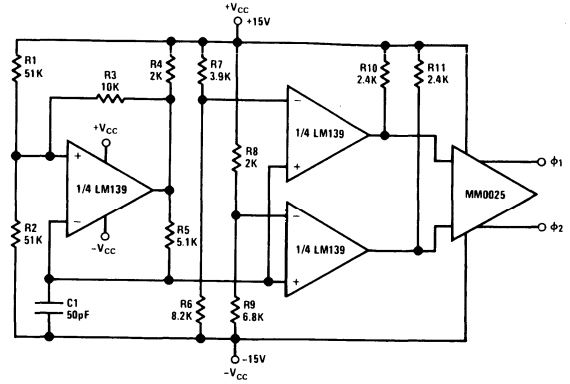
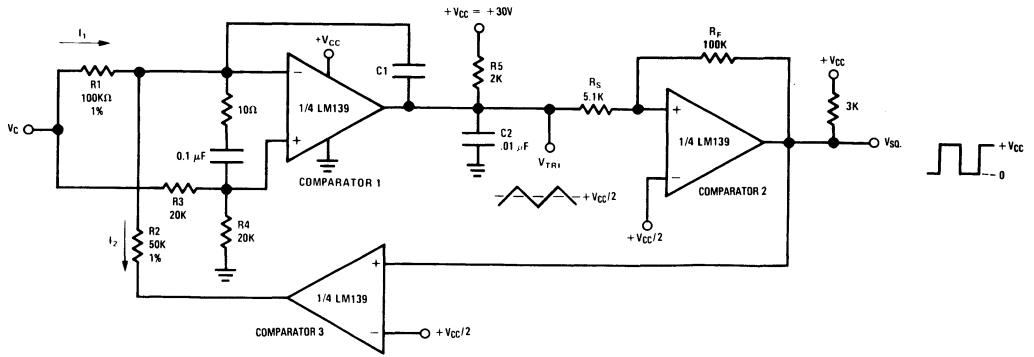


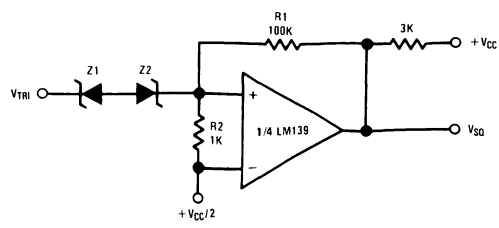
FIGURE 16. MOS Clock Driver

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(a)

TL/H/7385-17



(b)

TL/H/7385-18

FIGURE 17. Voltage Controlled Oscillator

flow through resistor R_2 to ground. If the value of R_2 is chosen as $R_1/2$ a current equal to the capacitor discharge current can be made to flow out of C_1 charging it at the same rate as it was discharged. By making $R_2 = R_1/2$, current I_2 will equal twice I_1 . This is the control circuitry which guarantees a constant 50% duty cycle oscillation independent of frequency or temperature. As capacitor C_1 charges, the output of comparator 1 will ramp up until it trips comparator 2 to its high state ($V_{SQ} = +V_{CC}$) and the cycle will repeat.

The circuit shown in Figure 17a uses a +30V supply and gives a triangle wave of 1.5V peak-to-peak. With a timing capacitor, C_1 equal to 500 pF, a frequency range from approximately 115 kHz down to approximately 670 Hz was obtained with a control voltage ranging from 50V down to 250 mV. By reducing the hysteresis around comparator 2 down to ± 150 mV ($R_f = 100$ k Ω , $R_S = 1$ k Ω) and reducing the compensating capacitor C_2 down to .001 μ F, frequencies up to 1 MHz may be obtained. For lower frequencies ($f_0 \leq 1$ Hz) the timing capacitor, C_1 , should be increased up to approximately 1 μ F to insure that the charging currents, I_1 and I_2 , are much larger than the input bias currents of comparator 1.

Figure 17b shows another interesting approach to provide the hysteresis for comparator 2. Two identical Zener diodes, Z_1 and Z_2 , are used to set the trip points of comparator 2. When the triangle wave is less than the value required to Zener one of the diodes, the resistive network, R_1 and R_2 , provides enough feedback to keep the comparator in its proper state, (the input would otherwise be floating). The advantage of this circuit is that the trip points of comparator 2 will be completely independent of supply voltage fluctuations. The disadvantage is that Zeners with less than one volt breakdown voltage are not obtainable. This limits the maximum upper frequency obtainable because of the larger amplitude of the triangle wave. If a regulated supply is available, Figure 17a is preferable simply because of less parts count and lower cost.

Both circuits provide good control over at least two decades in frequency with a temperature coefficient largely dependent on the TC of the external timing resistors and capacitors. Remember that good circuit layout is essential along with the 0.01 μ F compensation capacitor at the output of comparator 1 and the series 10 Ω , resistor and 0.1 μ F capacitor between its inputs, for proper operation. Comparator

1 is a high gain amplifier used closed loop as an integrator so long leads and loose layout should be avoided.

DIGITAL AND SWITCHING CIRCUITS

The LM139 lends itself well to low speed (<1 MHz) high level logic circuits. They have the advantage of operating with high signal levels, giving high noise immunity, which is highly desirable for industrial applications. The output signal level can be selected by setting the V_{CC} to which the pull-up resistor is connected to any desired level.

AND/NAND GATES

A three input AND gate is shown in Figure 18. Operation of this gate is as follows: resistor divider R_1 and R_2 establishes a reference voltage at the inverting input to the comparator. The non-inverting input is the sum of the voltages at the inputs divided by the voltage dividers comprised of R_3 , R_4 ,

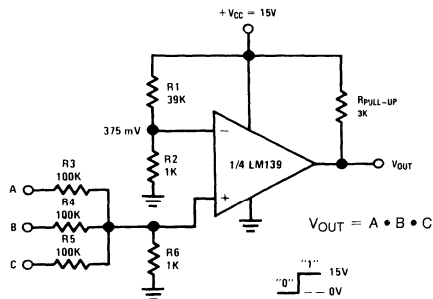


FIGURE 18. Three Input AND Gate

R_5 and R_6 . The output will go high only when all three inputs are high, causing the voltage at the non-inverting input to go above that at inverting input. The circuit values shown work for a "0" equal to ground and a "1" equal +15V. The resistor values can be altered if different logic levels are desired. If more inputs are required, diodes are recommended to improve the voltage margin when all but one of the inputs are the "1" state. This circuit with increased fan-in is shown in Figure 19.

To convert these AND gates to NAND gates simply interchange the inverting and non-inverting inputs to the comparator. Hysteresis can be added to speed up output transitions if low speed input signals are used.

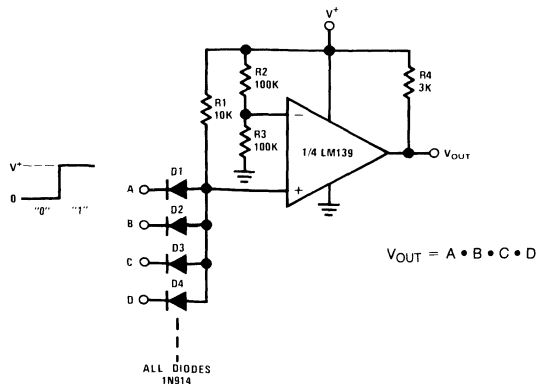
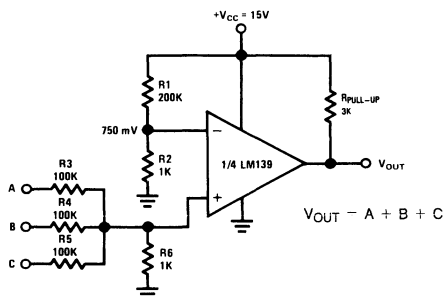


FIGURE 19. AND Gate with Large Fan-In

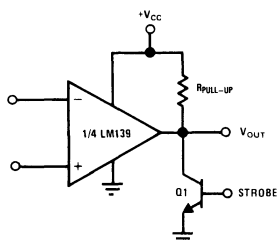
OR/NOR GATES

The three input OR gate (positive logic) shown in *Figure 20* is achieved from the basic AND gate simply by increasing R_1 thereby reducing the reference voltage. A logic "1" at any of the inputs will produce a logic "1" at the output. Again a NOR gate may be implemented by simply reversing the comparator inputs. Resistor R_6 may be added for the OR or NOR function at the expense of noise immunity if so desired.



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FIGURE 20. Three Input OR Gate



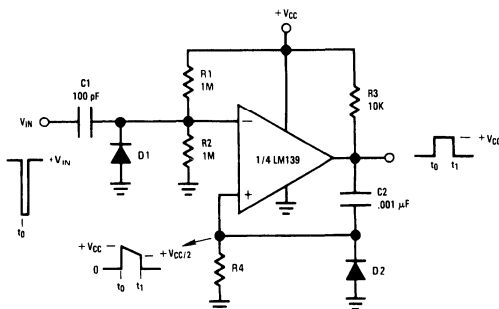
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FIGURE 21. Output Strobing Using a Discrete Transistor

OUTPUT STROBING

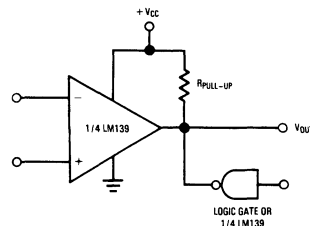
The output of the LM139 may be disabled by adding a clamp transistor as shown in *Figure 21*. A strobe control voltage at the base of Q_1 will clamp the comparator output to ground, making it immune to any input changes.

If the LM139 is being used in a digital system the output may be strobed using any other type of gate having an uncommitted collector output (such as National's DM5401/DM7401). In addition another comparator of the LM139 could also be used for output strobing, replacing Q_1 in *Figure 21*, if desired. (See *Figure 22*.)



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FIGURE 23. One Shot Multivibrator



TL/H/7385-23

FIGURE 22. Output Strobing with TTL Gate

ONE SHOT MULTIVIBRATORS

A simple one shot multivibrator can be realized using one comparator of the LM139 as shown in *Figure 23*. The output pulse width is set by the values of C_2 and R_4 (with $R_4 > 10 R_3$ to avoid loading the output). The magnitude of the input trigger pulse required is determined by the resistive divider R_1 and R_2 . Temperature stability can be achieved by balancing the temperature coefficients of R_4 and C_2 or by using components with very low TC. In addition, the TC of resistors R_1 and R_2 should be matched so as to maintain a fixed reference voltage of $+V_{CC}/2$. Diode D_2 provides a rapid discharge path for capacitor C_2 to reset the one shot at the end of its pulse. It also prevents the non-inverting input from being driven below ground. The output pulse width is relatively independent of the magnitude of the supply voltage and will change less than 2% for a five volt change in $+V_{CC}$.

The one shot multivibrator shown in *Figure 24* has several characteristics which make it superior to that shown in *Figure 23*. First, the pulse width is independent of the magnitude of the power supply voltage because the charging voltage and the intercept voltage are a fixed percentage of $+V_{CC}$. In addition this one-shot is capable of 99% duty cycle and exhibits input trigger lock-out to insure that the circuit will not re-trigger before the output pulse has been completed. The trigger level is the voltage required at the input to raise the voltage at point A higher than the voltage at point B, and is set by the resistive divider R_4 and R_{10} and the network R_1 , R_2 and R_3 . When the multivibrator has been triggered, the output of comparator 2 is high causing the reference voltage at the non-inverting input of comparator 1 to go to $+V_{CC}$. This prevents any additional input pulses from disturbing the circuit until the output pulse has been completed.

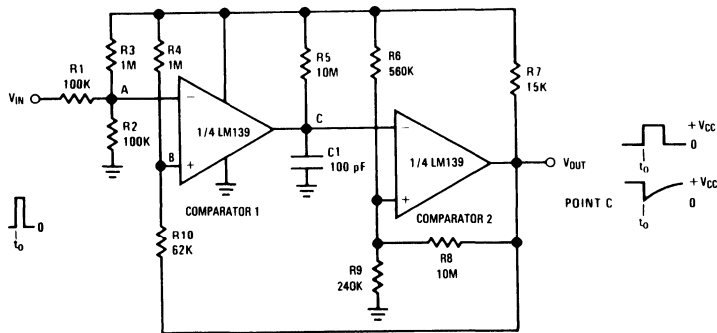


FIGURE 24. Multivibrator with Input Lock-Out

TL/H/7385-25

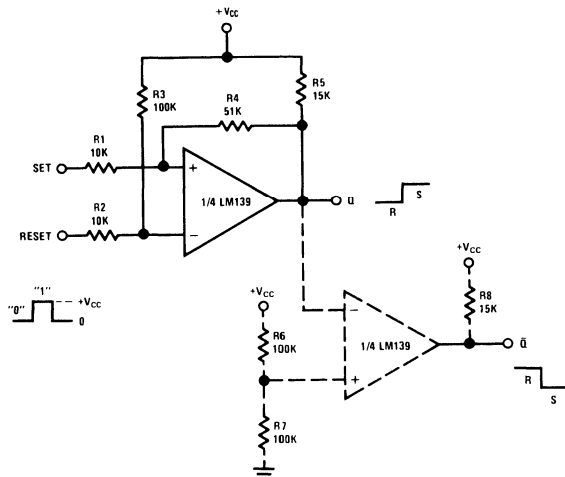


FIGURE 25. Bistable Multivibrator.

TL/H/7385-26

The value of the timing capacitor, C_1 , must be kept small enough to allow comparator 1 to completely discharge C_1 before the feedback signal from comparator 2 (through R_{10}) switches comparator 1 OFF and allows C_1 to start an exponential charge. Proper circuit action depends on rapidly discharging C_1 to a value set by R_6 and R_9 at which time comparator 2 latches comparator 1 OFF. Prior to the establishment of this OFF state, C_1 will have been completely discharged by comparator 1 in the ON state. The time delay, which sets the output pulse width, results from C_1 recharging to the reference voltage set by R_6 and R_9 . When the voltage across C_1 charges beyond this reference, the output pulse returns to ground and the input is again reset to accept a trigger.

BISTABLE MULTIVIBRATOR

Figure 25 is the circuit of one comparator of the LM139 used as a bistable multivibrator. A reference voltage is provided at the inverting input by a voltage divider comprised of R_2 and R_3 . A pulse applied to the SET terminal will switch the output high. Resistor divider network R_1 , R_4 , and R_5 now clamps the non-inverting input to a voltage greater than the reference voltage. A pulse now applied to the RESET Input will pull the output low. If both Q and \bar{Q} outputs are needed, another comparator can be added as shown dashed in Figure 25.

Figure 26 shows the output saturation voltage of the LM139 comparator versus the amount of current being passed to ground. The end point of 1 mV at zero current along with an R_{SAT} of 60Ω shows why the LM139 so easily adapts itself to oscillator and digital switching circuits by allowing the DC output voltage to go practically to ground while in the ON state.

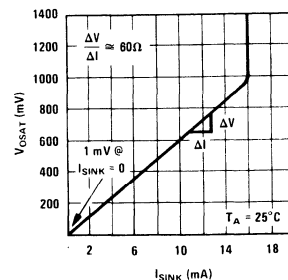


FIGURE 26. Typical Output Saturation Characteristics

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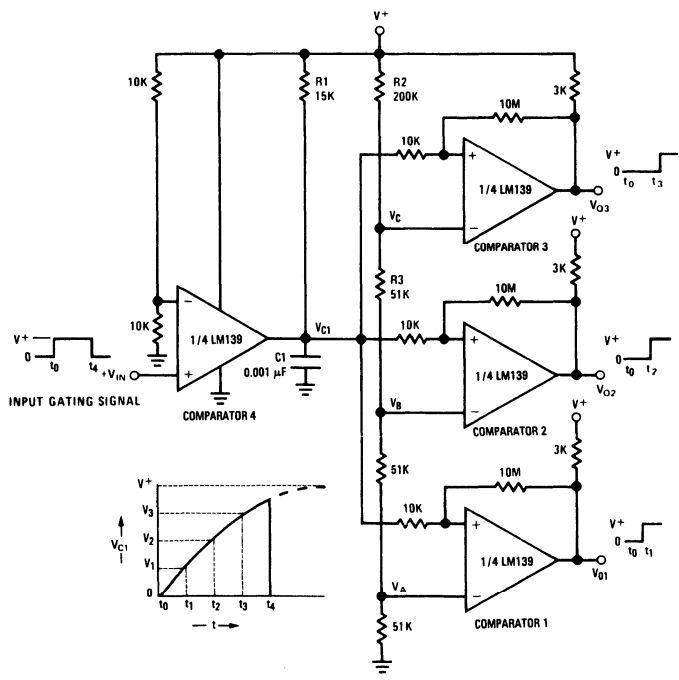


FIGURE 27. Time Delay Generator

TL/H/7385-28

TIME DELAY GENERATOR

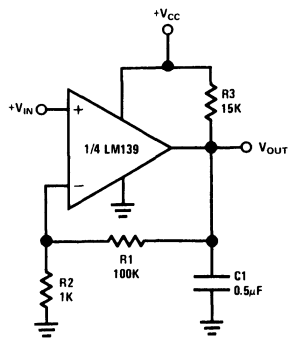
The final circuit to be presented "Digital and Switching Circuits" is a time delay generator (or sequence generator) as shown in Figure 27.

This timer will provide output signals at prescribed time intervals from a time reference t_0 and will automatically reset when the input signal returns to ground. For circuit evaluation, first consider the quiescent state ($V_{IN} = 0$) where the output of comparator 4 is ON which keeps the voltage across C_1 at zero volts. This keeps the outputs of comparators 1, 2 and 3 in their ON state ($V_{OUT} = GND$). When an input signal is applied, comparator 4 turns OFF allowing C_1 to charge at an exponential rate through R_1 . As this voltage rises past the present trip points V_A , V_B , and V_C of comparators 1, 2 and 3 respectively, the output voltage of each of these comparators will switch to the high state ($V_{OUT} = +V_{CC}$). A small amount of hysteresis has been provided to insure fast switching for the case where the R_C time constant has been chosen large to give long delay times. It is not necessary that all comparator outputs be low in the quiescent state. Several or all may be reversed as desired simply by reversing the inverting and non-inverting input connections. Hysteresis again is optional.

LOW FREQUENCY OPERATIONAL AMPLIFIERS

The LM139 comparator can be used as an operational amplifier in DC and very low frequency AC applications (≤ 100 Hz). An interesting combination is to use one of the comparators as an op amp to provide a DC reference voltage for the other three comparators in the same package. Another useful application of an LM139 has the interesting feature that the input common mode voltage range includes ground even though the amplifier is biased from a single supply and ground. These op amps are also low power drain

devices and will not drive large load currents unless current boosted with an external NPN transistor. The largest application limitation comes from a relatively slow slew rate which restricts the power bandwidth and the output voltage response time.



$$A_v = 1 + \frac{R_1}{R_2} = 101$$

TL/H/7385-29

FIGURE 28. Non-Inverting Amplifier

The LM139, like other comparators, is not internally frequency compensated and does not have internal provisions for compensation by external components. Therefore, compensation must be applied at either the inputs or output of the device. Figure 28 shows an output compensation scheme which utilizes the output collector pull-up resistor working with a single compensation capacitor to form a dominant pole. The feedback network, R_1 and R_2 sets the

closed loop gain at $1 + R_1/R_2$ or 101 (40 dB). *Figure 29* shows the output swing limitations versus frequency. The output current capability of this amplifier is limited by the relatively large pull-up resistor (15 k Ω) so the output is shown boosted with an external NPN transistor in *Figure 30*. The frequency response is greatly extended by the use

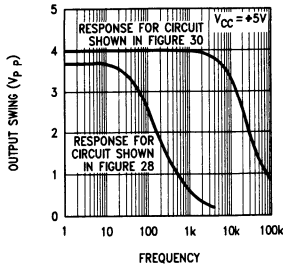


FIGURE 29. Large Signal Frequency Response

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of the new compensation scheme also shown in *Figure 30*. The DC level shift due to the V_{BE} of Q_1 allows the output

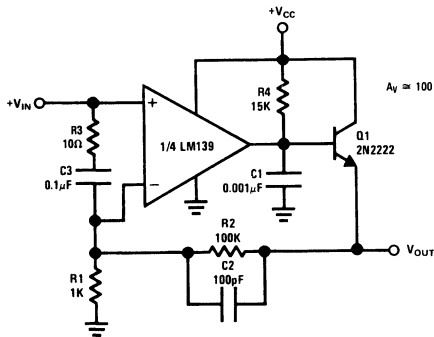


FIGURE 30. Improved Operational Amplifier

TL/H/7385-31

voltage to swing from ground to approximately one volt less than $+V_{CC}$. A voltage offset adjustment can be added as shown in *Figure 31*.

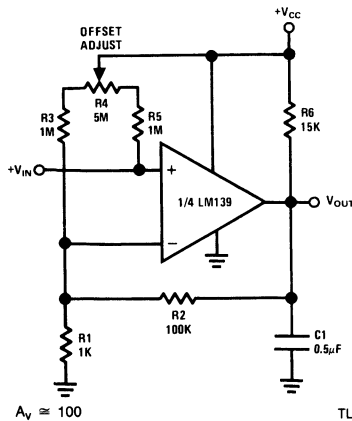


FIGURE 31. Input Offset Null Adjustment

TL/H/7385-32

DUAL SUPPLY OPERATION

The applications presented here have been shown biased typically between $+V_{CC}$ and ground for simplicity. The LM139, however, works equally well from dual (plus and minus) supplies commonly used with most industry standard op amps and comparators, with some applications actually requiring fewer parts than the single supply equivalent.

The zero crossing detector shown in *Figure 10* can be implemented with fewer parts as shown in *Figure 32*. Hysteresis has been added to insure fast transitions if used with slowly moving input signals. It may be omitted if not needed, bringing the total parts count down to one pull-up resistor.

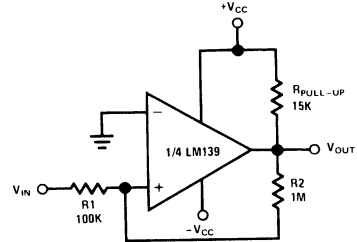


FIGURE 32. Zero Crossing Detector Using Dual Supplies

TL/H/7385-33

The MOS clock driver shown in *Figure 16* uses dual supplies to properly drive the MM0025 clock driver.

The square wave generator shown in *Figure 13* can be used with dual supplies giving an output that swings symmetricaly above and below ground (see *Figure 33*). Operation is identical to the single supply oscillator with only change being in the lower trip point.

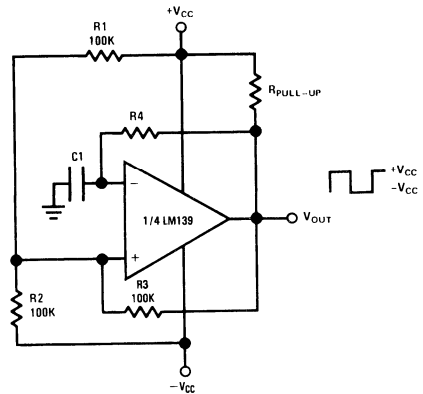


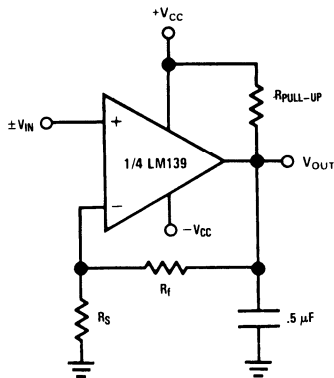
FIGURE 33. Squarewave Generator Using Dual Supplies

TL/H/7385-34

Figure 34 shows an LM139 connected as an op amp using dual supplies. Biasing is actually simpler if full output swing at low gain settings is required by biasing the inverting input from ground rather than from a resistive divider to some voltage between $+V_{CC}$ and ground.

All the applications shown will work equally well biased with dual supplies. If the total voltage across the device is increased from that shown, the output pull-up resistor should

be increased to prevent the output transistor from being pulled out of saturation by drawing excessive current, thereby preventing the output low state from going all the way to $-V_{CC}$.



TL/H/7385-35

FIGURE 34. Non-Inverting Amplifier Using Dual Supplies

MISCELLANEOUS APPLICATIONS

The following is a collection of various applications intended primarily to further show the wide versatility that the LM139 quad comparator has to offer. No new modes of operation are presented here so all of the previous formulas and circuit descriptions will hold true. It is hoped that all of the circuits presented in this application note will suggest to the user a few of the many areas in which the LM139 can be utilized.

REMOTE TEMPERATURE SENSOR/ALARM

The circuit shown in *Figure 35* shows a temperature over-range limit sensor. The 2N930 is a National process 07 silicon NPN transistor connected to produce a voltage reference equal to a multiple of its base emitter voltage along with temperature coefficient equal to a multiple of $2.2 \text{ mV}/^\circ\text{C}$.

That multiple is determined by the ratio of R_1 to R_2 . The theory of operation is as follows: with transistor Q_1 biased

up, its base to emitter voltage will appear across resistor R_1 . Assuming a reasonably high beta ($\beta \geq 100$) the base current can be neglected so that the current that flows through resistor R_1 must also be flowing through R_2 . The voltage drop across resistor R_2 will be given by:

$$I_{R1} = I_{R2}$$

and

$$V_{R1} = V_{be} = I_{R1} R_1$$

so

$$V_{R2} = I_{R2} R_2 = I_{R1} R_2 = V_{be} \frac{R_2}{R_1} \quad (31)$$

As stated previously this base-emitter voltage is strongly temperature dependent, minus $2.2 \text{ mV}/^\circ\text{C}$ for a silicon transistor. This temperature coefficient is also multiplied by the resistor ratio R_1/R_2 .

This provides a highly linear, variable temperature coefficient reference which is ideal for use as a temperature sensor over a temperature range of approximately -65°C to $+150^\circ\text{C}$. When this temperature sensor is connected as shown in *Figure 35* it can be used to indicate an alarm condition of either too high or too low a temperature excursion. Resistors R_3 and R_4 set the trip point reference voltage, V_B , with switching occurring when $V_A = V_B$. Resistor R_5 is used to bias up Q_1 at some low value of current simply to keep quiescent power dissipation to a minimum. An I_Q near $10 \mu\text{A}$ is acceptable.

Using one LM139, four separate sense points are available. The outputs of the four comparators can be used to indicate four separate alarm conditions or the outputs can be OR'ed together to indicate an alarm condition at any one of the sensors. For the circuit shown the output will go HIGH when the temperature of the sensor goes above the preset level. This could easily be inverted by simply reversing the input leads. For operation over a narrow temperature range, the resistor ratio R_2/R_1 should be large to make the alarm more sensitive to temperature variations. To vary the trip points a potentiometer can be substituted for R_3 and R_4 . By the ad-

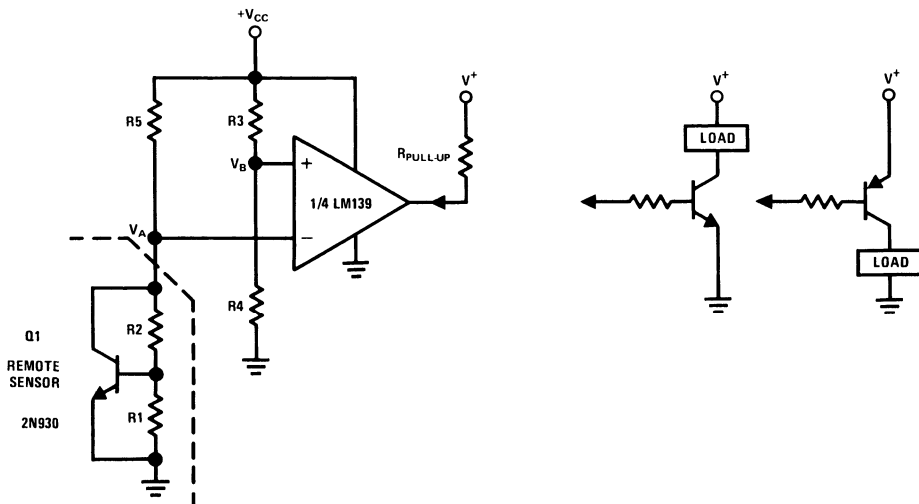
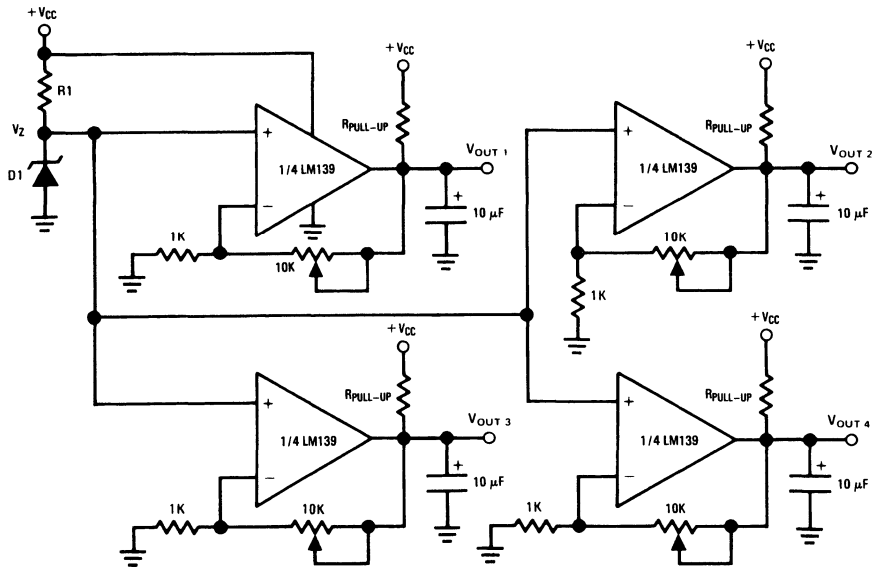


FIGURE 35. Temperature Alarm

TL/H/7385-36



TL/H/7385-37

FIGURE 36. Four Variable Reference Supplies

dition of a single feedback resistor to the non-inverting input to provide a slight amount of hysteresis, the sensor could function as a thermostat. For driving loads greater than 15 mA, an output current booster transistor could be used.

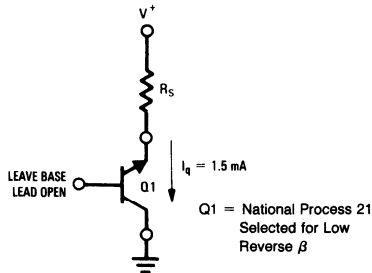
FOUR INDEPENDENTLY VARIABLE, TEMPERATURE COMPENSATED, REFERENCE SUPPLIES

The circuit shown in Figure 36 provides four independently variable voltages that could be used for low current supplies for powering additional equipment or for generating the reference voltages needed in some of the previous comparator applications. If the proper Zener diode is chosen, these four voltages will have a near zero temperature coefficient. For industry standard Zeners, this will be somewhere between 5.0 and 5.4V at a Zener current of approximately 10 mA. An alternative solution is offered to reduce this 50 mW quiescent power drain. Experimental data has shown that any of National's process 21 transistors which have been selected for low reverse beta ($\beta_R < .25$) can be used

quite satisfactorily as a zero T.C. Zener. When connected as shown in Figure 37, the T.C. of the base-emitter Zener voltage is exactly cancelled by the T.C. of the forward biased base-collector junction if biased at 1.5 mA. The diode can be properly biased from any supply by adjusting R_S to set I_q equal to 1.5 mA. The outputs of any of the reference supplies can be current boosted by using the circuit shown in Figure 30.

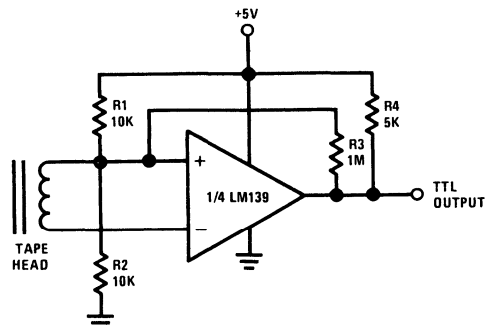
DIGITAL TAPE READER

Two circuits are presented here—a tape reader for both magnetic tape and punched paper tape. The circuit shown in Figure 38, the magnetic tape reader, is the same as Figure 12 with a few resistor values changed. With a 5V supply, to make the output TTL compatible, and a 1 M Ω feedback resistor, ± 5 mV of hysteresis is provided to insure fast switching and higher noise immunity. Using one LM139, four tape channels can be read simultaneously.



TL/H/7385-38

FIGURE 37. Zero T.C. Zener



TL/H/7385-39

FIGURE 38. Magnetic Tape Reader with TTL Output

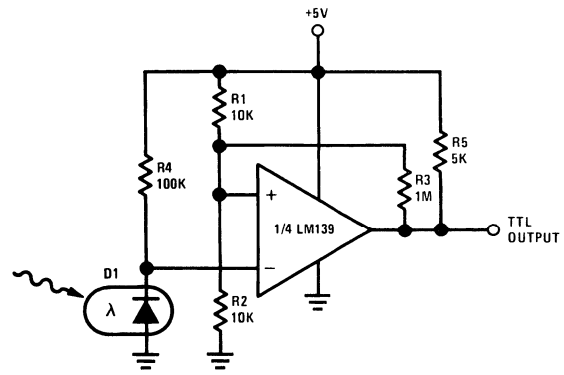


FIGURE 39. Paper Tape Reader With TTL Output

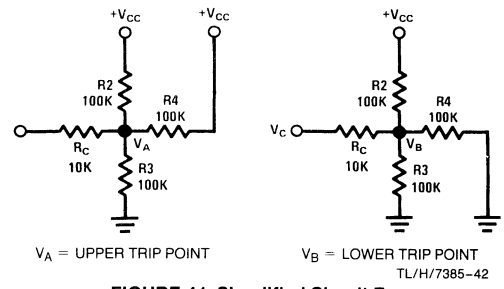
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The paper tape reader shown in Figure 39 is essentially the same circuit as Figure 38 with the only change being in the type of transducer used. A photo-diode is now used to sense the presence or absence of light passing through holes in the tape. Again a 1 MΩ feedback resistor gives ±5 mV of hysteresis to insure rapid switching and noise immunity.

PULSE WIDTH MODULATOR

Figure 40 shows the circuit for a simple pulse width modulator circuit. It is essentially the same as that shown in Figure 13 with the addition of an input control voltage. With the input control voltage equal to +V_{CC}/2, operation is basically the same as that described previously. If the input control voltage is moved above or below +V_{CC}/2, however, the duty cycle of the output square wave will be altered. This is because the addition of the control voltage at the input has now altered the trip points. These trip points can be found if the circuit is simplified as in Figure 41. Equations 13 through 20 are still applicable if the effect of R_C is added, with equations 17 through 20 being altered for condition where V_C ≠ +V_{CC}/2.

Pulse width sensitivity to input voltage variations will be increased by reducing the value of R_C from 10 kΩ and alternately, sensitivity will be reduced by increasing the value of



V_A = UPPER TRIP POINT

V_B = LOWER TRIP POINT

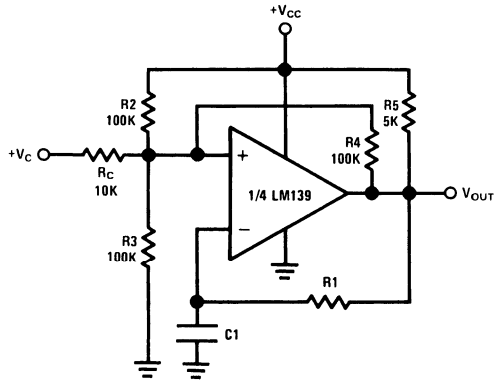
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FIGURE 41. Simplified Circuit For Calculating Trip Points of Figure 40

R_C. The values of R₁ and C₁ can be varied to produce any desired center frequency from less than one hertz to the maximum frequency of the LM139 which will be limited by +V_{CC} and the output slew rate.

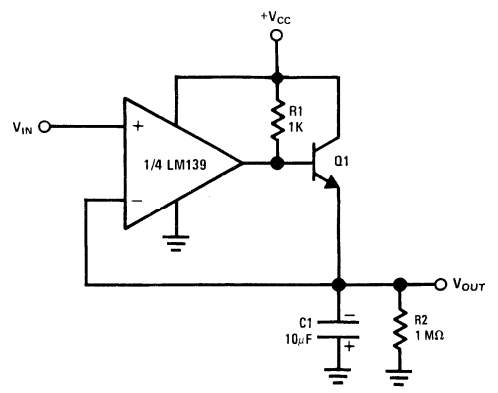
POSITIVE AND NEGATIVE PEAK DETECTORS

Figures 42 and 43 show the schematics for simple positive or negative peak detectors. Basically the LM139 is operated closed loop as a unity gain follower with a large holding capacitor from the output to ground. For the positive peak detector a low impedance current source is needed so an additional transistor is added to the output. When the output



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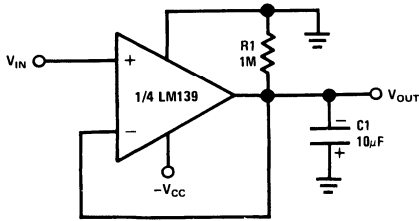
FIGURE 40. Pulse Width Modulator



TL/H/7385-43

FIGURE 42. Positive Peak Detector

of the comparator goes high, current is passed through Q_1 to charge up C_1 . The only discharge path will be the $1\text{ M}\Omega$ resistor shunting C_1 and any load that is connected to V_{OUT} . The decay time can be altered simply by changing the $1\text{ M}\Omega$ resistor higher or lower as desired. The output should be used through a high impedance follower to avoid loading the output of the peak detector.



TL/H/7385-44

FIGURE 43. Negative Peak Detector

For the negative peak detector, a low impedance current sink is required and the output transistor of the LM139 works quite well for this. Again the only discharge path will be the $1\text{ M}\Omega$ resistor and any load impedance used. Decay time is changed by varying the $1\text{ M}\Omega$ resistor.

CONCLUSION

The LM139 is an extremely versatile comparator package offering reasonably high speed while operating at power levels in the low mW region. By offering four independent comparators in one package, many logic and other functions can now be performed at substantial savings in circuit complexity, parts count, overall physical dimensions, and power consumption.

For limited temperature range application, the LM239 or LM339 may be used in place of the LM139.

It is hoped that this application note will provide the user with a guide for using the LM139 and also offer some new application ideas.

Applications for a High Speed FET Input Op Amp

National Semiconductor
Application Note 75



AN-75

INTRODUCTION

The principal limitations in speed and bandwidth in IC FET input op amps have been reduced by over an order of magnitude with the introduction of the LH0062/LH0062C. Internal compensation assures unity gain stability with bandwidths in excess of 15 MHz. Voltage follower slew rate is typically $75 \text{ V}/\mu\text{s}$ and is guaranteed in excess of $50 \text{ V}/\mu\text{s}$. Furthermore, external components may be used to extend the slew rate to $120 \text{ V}/\mu\text{s}$ and settling times under $1 \mu\text{s}$. The LH0062H (TO-5) is pin compatible with LM101, LM741 and LH0022. A summary of the LH0062's performance characteristics is given in Table I.

CIRCUIT DESCRIPTION

The LH0062 is basically a two stage amplifier (Figure 1) consisting of a N channel junction FET input stage (Q₁ and

Q₂) and a PNP output stage (Q₄ and Q₅). Q₁ and Q₂ are a well matched interdigitated monolithic pair that provide high common mode rejection and input offset voltage tracking usually associated only with bipolar designs. The current mirror (Q₆ and Q₇) converts to single ended operation in addition to providing active high impedance load for Q₄ and Q₅ thus providing high gain. Q₃ and D₁ provide a temperature compensated current source for the input stage and Q₈, Q₉, D₂ and D₃ form a class AB output buffer. Detailed schematic is illustrated in Figure 2. Note that the FET inputs are protected by 5V zener diodes and input current under transient conditions should be limited by inserting a 1 k Ω or larger resistor in series with one of the inputs.

TABLE I. Summary of LH0062 Characteristics

Parameter (T _A = 25°C)	Min	Typ	Max	Units
Input Offset Voltage		2.0	5.0	mV
Input Bias Current			20	pA
Voltage Gain	50	100		V/mV
Slew Rate	50	75		V/ μs
Bandwidth		15		MHz

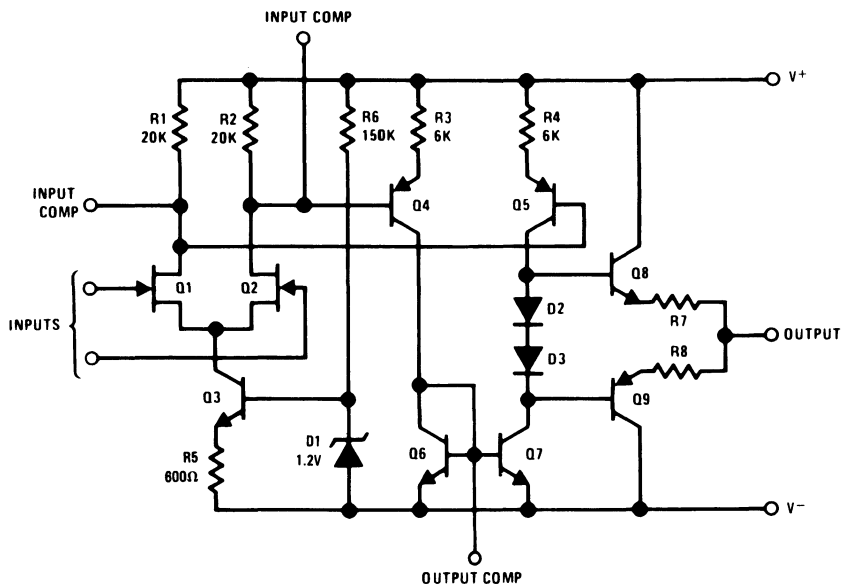
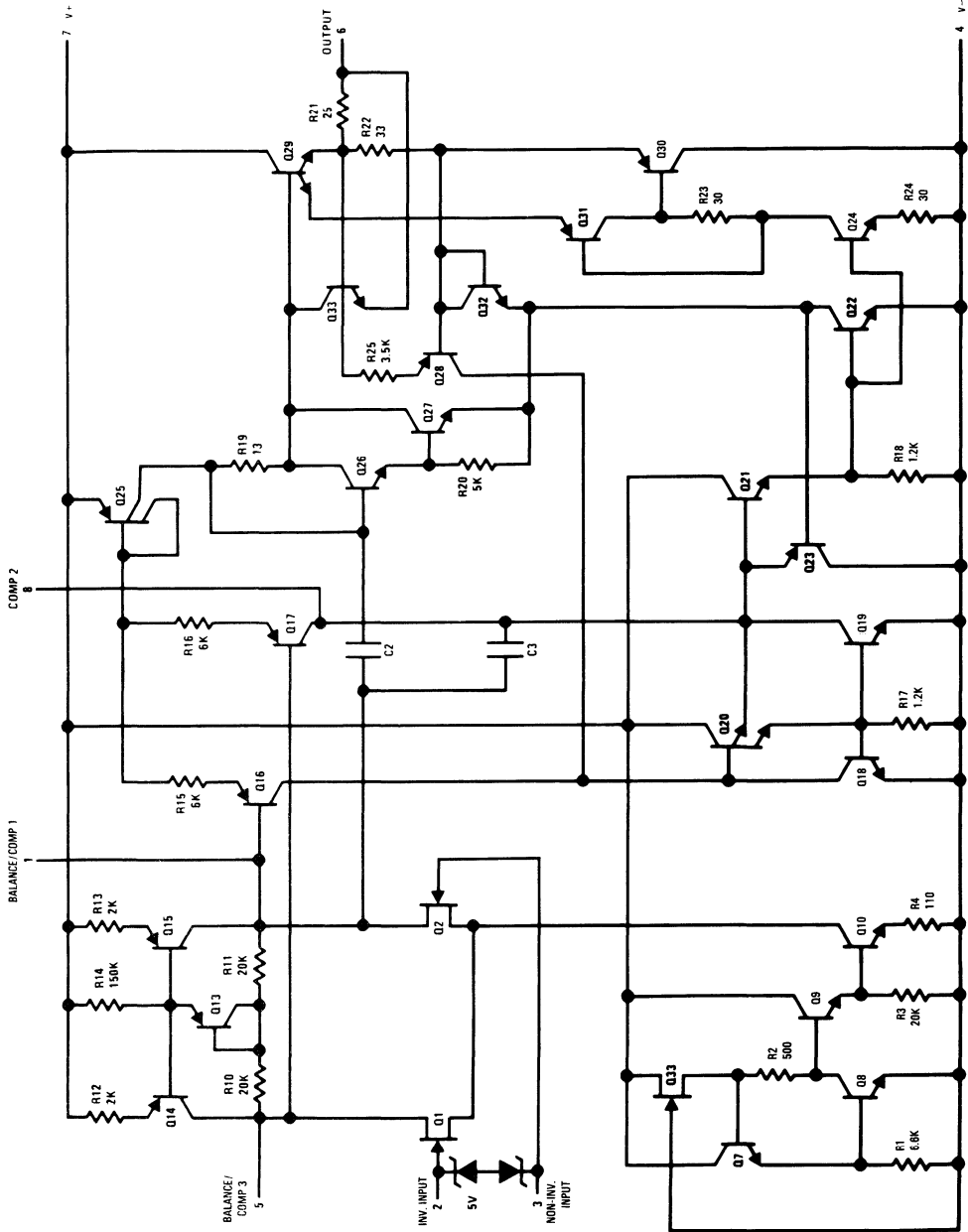


FIGURE 1. Simplified LH0062 Circuit Schematic

TL/K/7321-1



TLK/7321-2

FIGURE 2. Complete LH0062 Schematic

COMPENSATION CONSIDERATIONS

As noted earlier, the LH0062 is internally compensated for unity gain stability. However, a few precautions are advised. Like most wide band amplifiers, the LH0062 is sensitive to power supply inductance, and decoupling the supplies with $0.1 \mu\text{F}$ ceramic disc capacitors within an inch or two of the device will prevent spurious oscillations and save a fair

amount of grief. The device is capable of driving 50 pF to 100 pF loads; for larger loads, an isolation resistor, R_3 as shown in *Figure 3* is recommended. Alternatively, a current buffer such as the LH0002 or LH0033 may be used for loads in excess of 500 pF with no degradation in slew rate as shown in *Figure 4*.

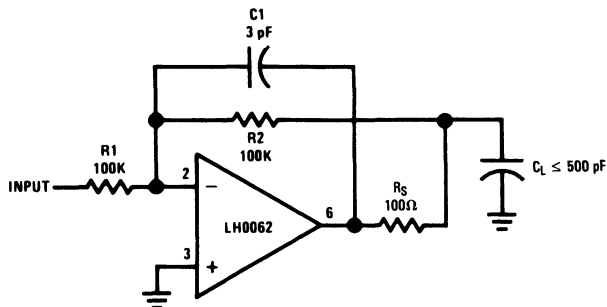


FIGURE 3. Isolating a Capacitive Load up to 500 pF

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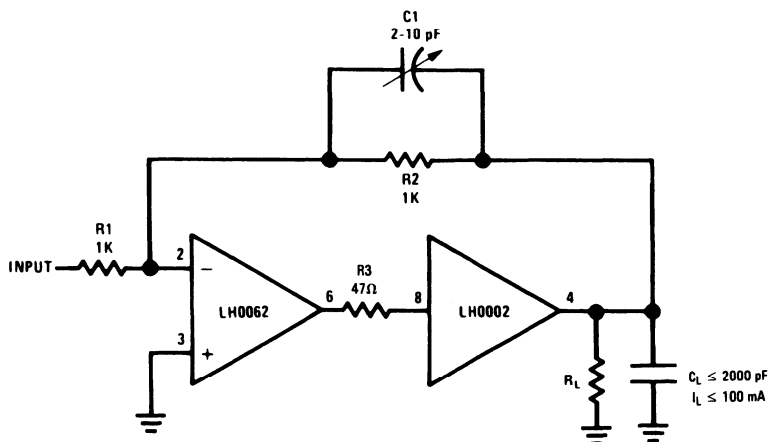


FIGURE 4. Driving Capacitances in Excess of 500 pF and Loads

TL/K/7321-4

Note: In the examples above, at a small capacitor, C_1 , is used to cancel the effects of stray capacitance at the input.

The LH0062 may be feed-forward compensated in inverting mode applications as shown in *Figure 5*. This boosts slew rate to over 120 V/μs and bandwidth to over 30 MHz. When full bandwidth is not required, the device may be over-compensated as shown in *Figure 6* to reduce bandwidth to 5 MHz. This technique improves phase margin and reduces susceptibility to spurious oscillations in applications where speed is less critical.

Minimum settling time of less than 1 μs to 0.1% for a 20V input step is obtained as illustrated in *Figure 7*. A small tweak capacitor, C₁ is recommended to cancel stray board layout capacitance, C_S. Once best value of trimmer capacitor C₁ is determined for a particular layout, it may be replaced with a fixed value.

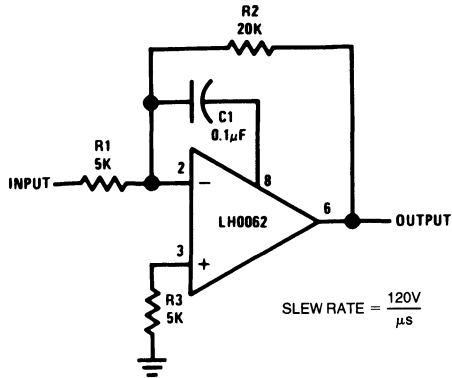


FIGURE 5. Feed Forward Compensation

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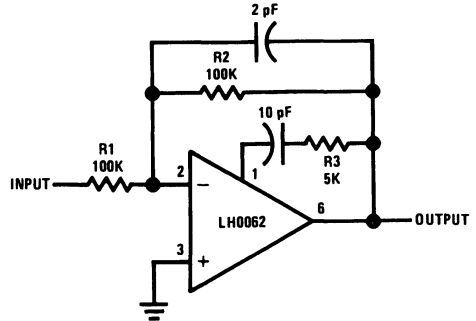


FIGURE 6. Overcompensation

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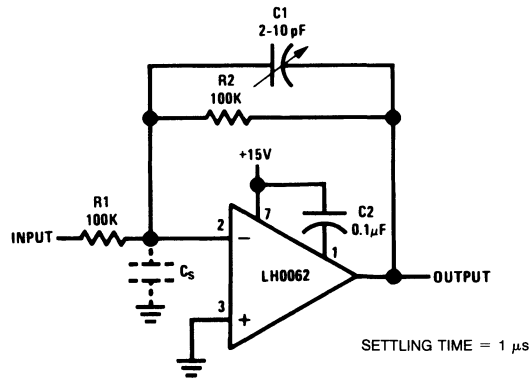


FIGURE 7. Compensation for Minimum Settling Time

TL/K/7321-7

APPLICATIONS

The circuit of *Figure 8* is a high speed sample and hold with sample acquisition time of $10 \mu\text{s}$ for 0.1% accuracy and aperture time of approximately 25 ns. Resistor, R_6 , is used to limit input current during power on and off transients. Although the inputs of the LH0062 are protected by back-to-back diodes excessive input current could damage the de-

vice. Resistor R_9 and the pot, R_8 , allow null of the output offset with negligible effect on offset drift.

The peak detector of *Figure 9* will acquire a +10V peak signal in under $4 \mu\text{s}$ with droop rates under 20 mV/sec. Reversing the polarity of diodes D_1 and D_2 will allow peak detecting negative signals. Any ultra-low leakage diode may be substituted for the 2N930 collector-base junction.

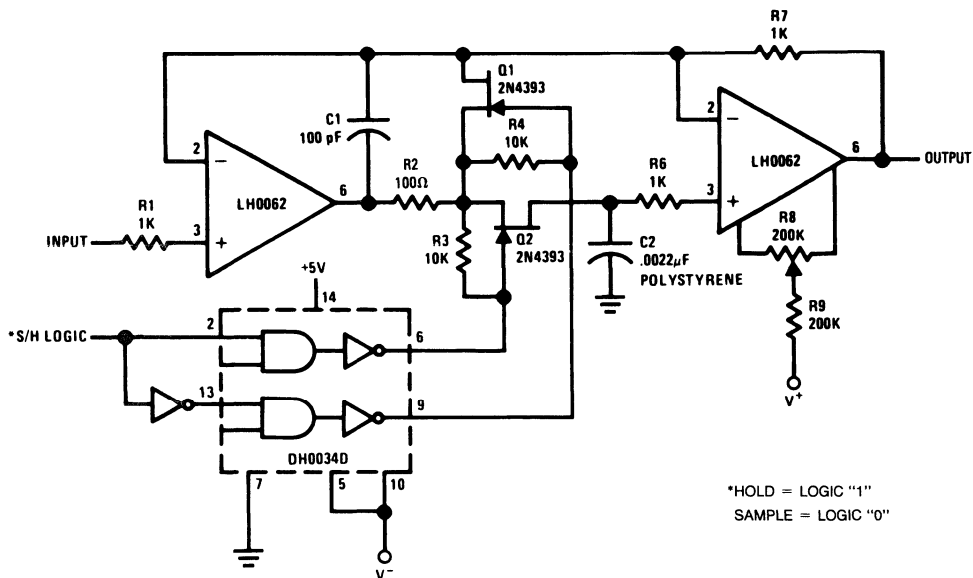


FIGURE 8. High Speed Sample and Hold

TL/K/7321-8

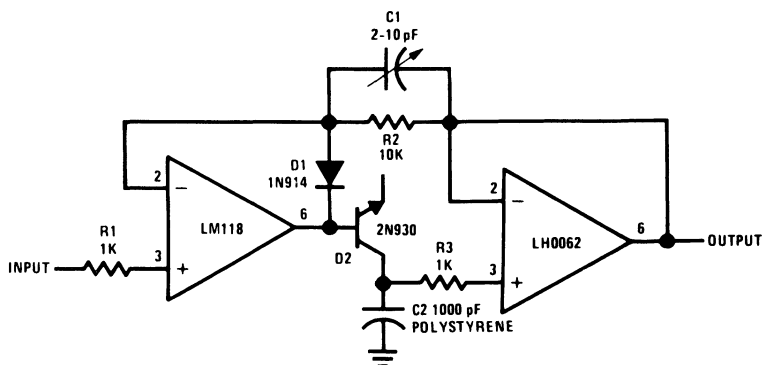
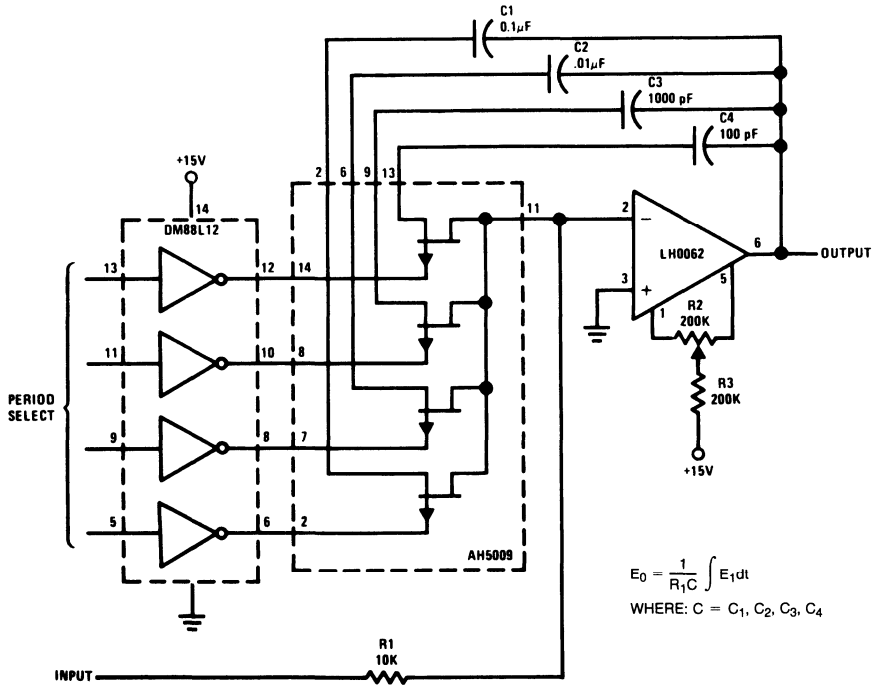


FIGURE 9. High Speed Peak Detector

TL/K/7321-9



$$E_0 = \frac{1}{R_1 C} \int E_1 dt$$

WHERE: C = C₁, C₂, C₃, C₄

FIGURE 10. Programmable Integrator

TL/K/7321-10

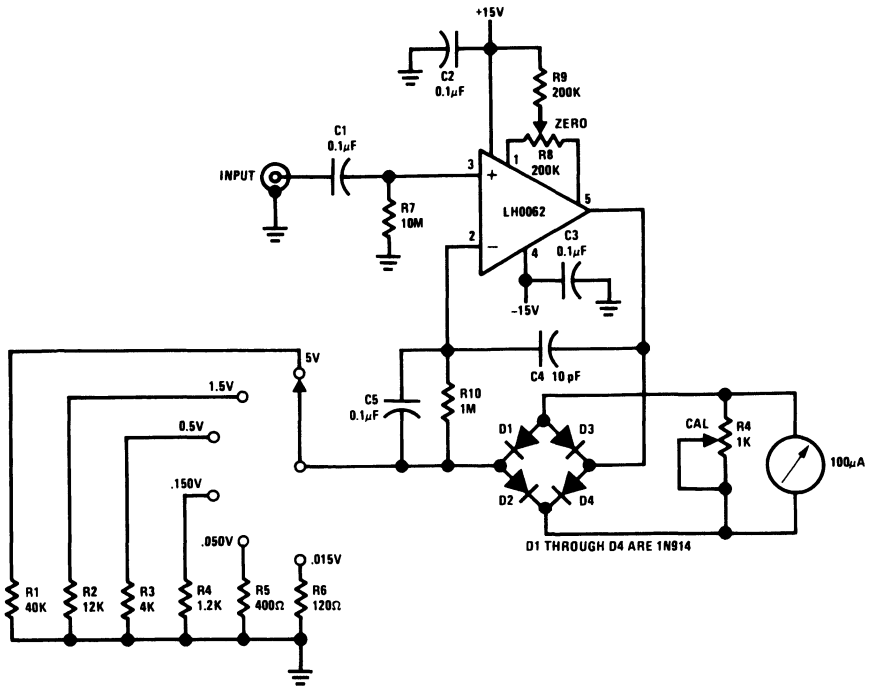


FIGURE 11. Wide Band AC Voltmeter

TL/K/7321-11

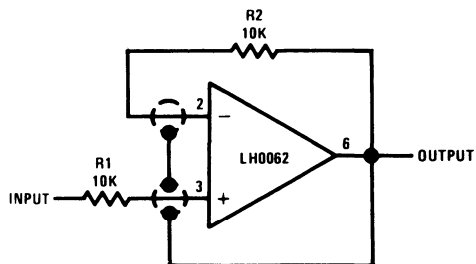
The circuit of *Figure 10* is a programmable integrator with a range in period from 1 μ s to 1 ms. For best results C_1 through C_4 should be low leakage construction such as polycarbonate or polystyrene. A simple method of implementing the offset adjustment is to momentarily insert a 100 k Ω resistor between pins 2 and 6 of the LH0062. With the switches of the AH5009 off, the output may be set to zero with R_2 .

The circuit of *Figure 11* is a wide band AC voltmeter capable of measuring AC signals as low as 15 mV at frequencies from 100 Hz to 500 kHz. Full scale sensitivity may be changed by altering the values R_1 through R_6 ($R \cong V_{IN}/100 \mu A$).

HEAT SINKING, GUARDING, AND BOOTSTRAPPING

The LH0062 is specified for operation without an external heat sink. However, standby power is typically 240 mW causing a junction rise of approximately 60°C. A clip-on heat sink can reduce internal heating hence reduce input bias current from 20 pA at 25°C ambient to 2 or 3 pA.

Guarding input leads is recommended in stringent applications. An excellent discussion on guarding is given in AN-63 and the techniques discussed are directly applicable to the LH0062. Another benefit of guarding is reduced input capacitance. By bootstrapping the inputs, as shown in *Figure 12*, the apparent input capacitance is reduced to fractions of a pico-farad.



TL/K/7321-12

FIGURE 12. Guard/Bootstrap for Unity Gain

Furthermore, the case of the LH0062 is electrically isolated, and the output may be tied to case in order to eliminate stray capacitance introduced by the header.

REFERENCES

1. R. K. Underwood, "New Design Techniques for FET Op Amps," National Semiconductor AN-63, March 1972.
2. R. C. Dobkin, "LM118 Op Amp Slews 70 V/ μ s," National Semiconductor LB-17, September 1971.

IC Preamplicifier Challenges Choppers on Drift

National Semiconductor
Application Note 79



Since the introduction of monolithic IC amplifiers there has been a continual improvement in DC accuracy. Bias currents have been decreased by 5 orders of magnitude over the past 5 years. Low offset voltage drift is also necessary in a high accuracy circuits. This is evidenced by the popularity of low drift amplifier types as well as the requests for selected low-drift op amps. However, until now the chopper stabilized amplifier offered the lowest drift. A new monolithic IC preamplifier designed for use with general purpose op amps improves DC accuracy to where the drift is lower than many chopper stabilized amplifiers.

INTRODUCTION

Chopper amplifiers have long been known to offer the lowest possible DC drift. They are not without problems, however. Most chopper amps can be used only as inverting amplifiers, limiting their applications. Chopping can introduce noise and spikes into the signal. Mechanical choppers need replacement as well as being shock sensitive. Further, chopper amplifiers are designed to operate over a limited power supply, limited temperature range.

Previous low-drift op amps do not provide optimum performance either. Selected devices may only meet their specified voltage drift under restrictive conditions. For example, if a 741 device is selected without offset nulling, the addition of an offset null pot can drastically change the drift. Low drift op amps designed for offset balancing have another problem. The resistor network used in the null circuit is designed to null the drift when the offset voltage is nulled. The mechanism to achieve nulled drift depends on the difference in temperature coefficient between the internal resistors and the external null pot. Since the internal resistors have a non-linear temperature coefficient and may vary device to device as well as between manufacturers, it can only approximately null offset drift. The problem gets worse if the external null pot has a TC other than zero.

A new IC preamplifier is now available which can give drifts as low as $0.2 \mu\text{V}/^\circ\text{C}$. It is used with conventional op amps and eliminates the problems associated with older devices. As well as improving the DC input characteristics of the op amp, loop-gain is increased when an LM121 is used. This further improves overall accuracy since DC gain error is decreased.

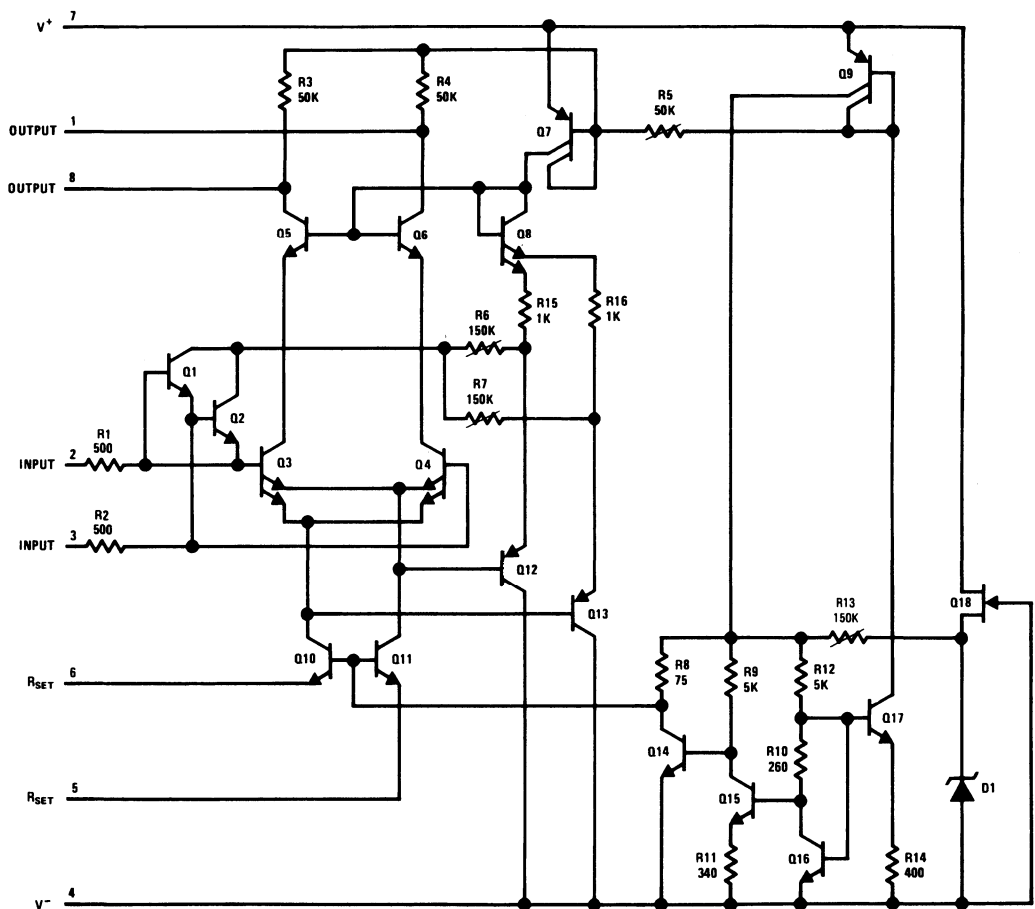
The LM121 preamp is designed to give zero drift when the offset voltage is nulled to zero. The operating current of the LM121 is programmable by the value of the null network

resistors. The drift is independent of the value of the nulling network so it can be used over a wide range of operating currents while retaining low drift. The operating current can be chosen to optimize bias current, gain, speed, or noise while still retaining the low drift. Further, since the drift is independent of the match between external and internal resistors when the offset is nulled, lower and more predictable drifts can be expected in actual use. The input is fully differential, overcoming many of the problems with single ended chopper-amps. The device also has enough common mode rejection ratio to allow the low drift to be fully utilized.

CIRCUIT DESCRIPTION

The LM121 is a well matched differential amplifier utilizing super-gain transistors as the input devices. A schematic is shown in *Figure 1*. The input signal is applied to the bases of Q_3 and Q_4 through protection resistors R_1 and R_2 . Q_3 and Q_4 have two emitters to allow offset balancing which will be explained later. The operating current for the differential amplifier is supplied by current sources Q_{10} and Q_{11} . The operating current is externally programmed by resistors connected from the emitters of Q_{10} and Q_{11} to the negative supply. Input transistors Q_3 and Q_4 are cascoded by transistors Q_5 and Q_6 to keep the collector base voltage on the input stage equal to zero. This eliminates leakage at high operating temperatures and keeps the common mode input voltage from appearing across the low breakdown super-gain input transistors. Additionally, the cascode improves the common mode rejection of the differential amplifier. Q_1 and Q_2 protect the input against large differential voltages.

The output signal is developed across resistive loads R_3 and R_4 . The total collector current of the input is then applied to the base of a fixed gain PNP, Q_7 . The collector current of Q_7 sets the operating current of Q_8 , Q_{12} , and Q_{13} . These transistors are used to set the operating voltage of the cascode, Q_5 and Q_6 . By operating the cascode biasing transistors at the same operating current as the input stage, it is possible to keep collector base voltage at zero; and therefore, collector-base leakage remains low over a wide current range. Further, this minimizes the effects of V_{BE} variations and finite transistor current gain. At high operating currents the collector base voltage of the input stage is increased by about 100 mV due to the drop across R_{15} and R_{16} . This prevents the input transistors from saturating under worst case conditions of high current and high operating temperature.



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*Pin connections shown on diagram and typical applications are for TO-5 package.

FIGURE 1. Schematic Diagram of the LM121

The rest of the devices comprise the turn-on and regulator circuitry. Transistors Q₁₄, Q₁₅, and Q₁₆ form a 1.2V regulator for the bases of the input stage current source. By fixing the bases of the current sources at 1.2V, their output current changes proportional to absolute temperature. This compensates for the temperature sensitivity of the input stage transconductance. Temperature compensating the transconductance makes the preamp more useful in some applications such as an instrumentation amplifier and minimizes bandwidth variations with temperature. The regulator is started by Q₁₈ and its operating current is supplied by Q₁₇ and Q₉. Figure 2 shows the LM121 chip.

OFFSET BALANCING

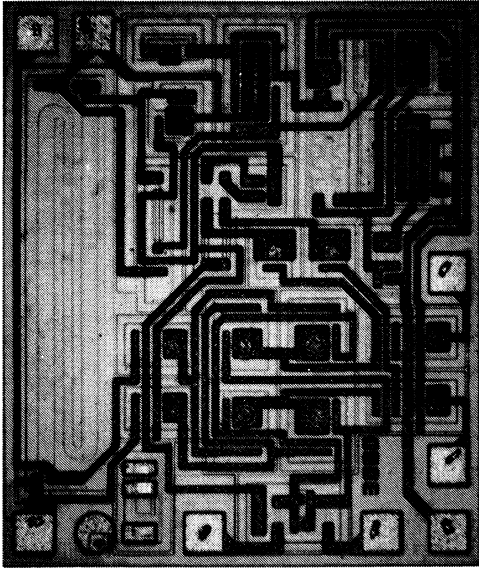
The LM121 was designed to operate with an offset balancing network connected to the current source transistors. The method of balancing the offset also minimizes the drift of the preamp. Unlike earlier devices such as the LM725,

the LM121 depends only upon the highly predictable emitter base voltages of transistors to achieve low drift. Devices like the LM725 depend on the match between internal resistor temperature coefficient and the external null pot as well as the input stage transistors characteristics for drift compensation.

The input stage of the LM121 is actually two differential amplifiers connected in parallel, each having a fixed offset. The offset is due to different areas for the transistor emitters. The offset for each pair is given by:

$$\Delta V_{BE} = \frac{kT}{q} \ln \frac{A_1}{A_2}$$

where k is Boltzmann's constant T is absolute temperature,



TL/H/7387-2

FIGURE 2. LM121 Chip

q is the charge on an electron, and A_1 and A_2 are emitter areas. Because of the offset, each pair has a fixed drift. When the pairs are connected in parallel, if they match, the offsets and drift cancel. However, since matching is not perfect, the emitters of the pairs are not connected in parallel, but connected to independent current sources to allow offset balancing. The offset and drift effect of each pair is proportional to its operating current, so varying the ratio of the current from current sources will vary both the offset and drift. When the offset is nulled to zero, the drift is nulled to below $1 \mu\text{V}/^\circ\text{C}$.

The offset balancing method used in the LM121 has several advantages over conventional balancing schemes. Firstly, as mentioned earlier, it theoretically zeros the drift and offset simultaneously. Secondly, since the maximum balancing range is fixed by transistor areas, the effect of null network variations on offset voltage is minimized. Resistor shifts of one percent only cause a $30 \mu\text{V}$ shift in offset voltage on the LM121, while a one percent shift in collector resistors on a standard diff amp causes a $300 \mu\text{V}$ offset change. Finally, it allows the value of the null network to set the operating current.

ACHIEVING LOW DRIFT

A very low drift amplifier poses some uncommon application and testing problems. Many sources of error can cause the apparent circuit drift to be much higher than would be predicted. In many cases, the low drift of the op amp is completely swamped by external effects while the amplifier is blamed for the high drift.

Thermocouple effects caused by temperature gradient across dissimilar metals are perhaps the worst offenders. Whenever dissimilar metals are joined, a thermocouple results. The voltage generated by the thermocouple is proportional to the temperature difference between the junction and the measurement end of the metal. This voltage can range between essentially zero and hundred of microvolts per degree, depending on the metals used. In any system

using integrated circuits a minimum of three metals are found: copper, solder, and kovar (lead material of the IC).

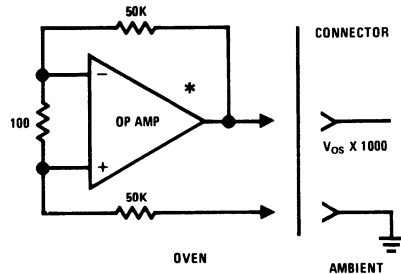
Nominally, most parts of a circuit are at the same temperature. However, a small temperature gradient can exist across even a few inches — and this is a big problem with low level signals. Only a few degrees gradient can cause hundreds of microvolts of error. The two places this shows up, generally are the package-to printed circuit board interface and temperature gradients across resistors. Keeping package leads short and the two input leads close together help greatly.

For example, a very low drift amplifier was constructed and the output monitored over a 1 minute period. During the 1 minute it appeared to have input referred offset variations of $\pm 5 \mu\text{V}$. Shielding the circuit from air currents reduced this to $\pm 0.5 \mu\text{V}$. The $10 \mu\text{V}$ error was due to thermal gradients across the circuit from air currents.

Resistor choice as well as physical placement is important for minimizing thermocouple effects. Carbon, oxide film and some metal film resistors can cause large thermocouple errors. Wirewound resistors of evenohm or managanin are best since they only generate about $2 \mu\text{V}/^\circ\text{C}$ referenced to copper. Of course, keeping the resistor ends at the same temperature is important. Generally, shielding a low drift stage electrically and thermally will yield good results.

Resistors can cause other errors besides gradient generated voltages. If the gain setting resistors do not track with temperature a gain error will result. For example a gain of 1000 amplifier with a constant 10 mV input will have a 10V output. If the resistors mistrack by 0.5% over the operating temperature range, the error at the output is 50 mV. Referred to input, this is a $50 \mu\text{V}$ error. Most precision resistors use different material for different ranges of resistor values. It is not unexpected that resistors differing by a factor of 1000, do not track perfectly with temperature. For best results insure that the gain fixing resistors are of the same material or have tracking temperature coefficients.

Testing low drift amplifiers is also difficult. Standard drift testing techniques such as heating the device in an oven and having the leads available through a connector, thermoprobe, or the soldering iron method — do not work. Thermal gradients cause much greater errors than the amplifier drift. Coupling microvolt signals through connectors is especially bad since the temperature difference across the connector can be 50°C or more. The device under test along with the gain setting resistor should be isothermal. The circuit in Figure 3 will yield good results if well constructed.



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*Op amp shown in Figure 9.

FIGURE 3. Drift Measurement Circuit

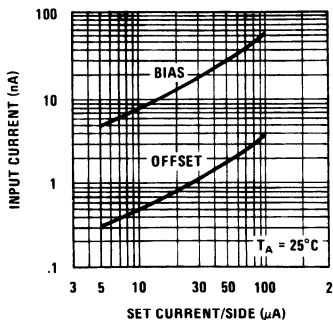
PERFORMANCE

It is somewhat difficult to specify the performance of the LM121 since it is programmable over a wide range of operating currents. Changing the operating current varies gain, bias current, and offset current — three critical parameters in a high accuracy system. However, offset voltage and drift are virtually independent of the operating current.

Typical performance at an operating current of 20 μA is shown in Table I. Figures 4 and 5 show how the bias current, offset current, and gain change as a function of programming current. Drift is guaranteed at 1 $\mu\text{V}/^\circ\text{C}$ independent of the operating current.

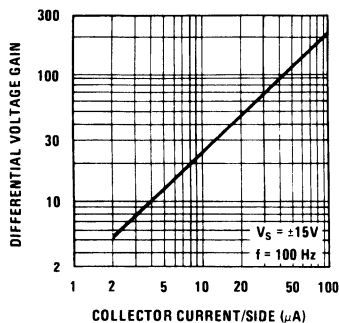
TABLE I. Typical Performance at an Operating Current of 10 μA Per Side

Offset Voltage	Nullled
Bias Current	7 nA
Offset Current	0.5 nA
Offset Voltage Drift	0.3 $\mu\text{V}/^\circ\text{C}$
Common Mode Rejection Ratio	125 dB
Supply Voltage Rejection Ratio	125 dB
Common Mode Range	$\pm 13\text{V}$
Gain	20 V/V
Supply Current	0.5 mA



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FIGURE 4. Bias and Offset Current vs Set Current



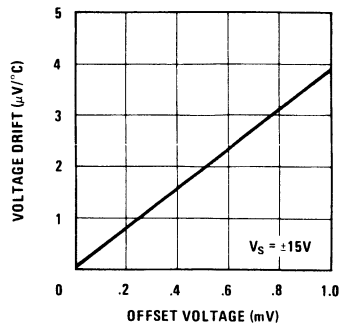
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FIGURE 5. Gain vs Set Current

Over a temperature range of -55°C to $+125^\circ\text{C}$ the LM121 has less than 1 $\mu\text{V}/^\circ\text{C}$ offset voltage drift when nullled. It is important that the offset voltage is accurately nullled to achieve this low drift. The drift is directly related to the offset voltage with 3.8 $\mu\text{V}/^\circ\text{C}$ drift resulting from every millivolt of

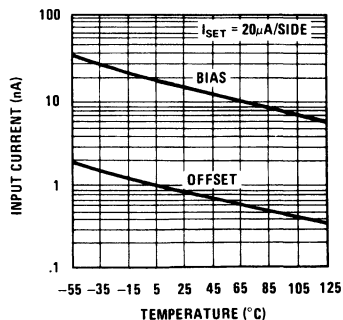
offset. For example, if the offset is nullled to 100 μV , about 0.4 $\mu\text{V}/^\circ\text{C}$ will result — or twice the typically expected drift. This drift is quite predictable and could even be used to cancel the drift elsewhere in a system. Figure 6 shows drift as a function of offset voltage. For critical applications selected devices can achieve 0.2 $\mu\text{V}/^\circ\text{C}$.

Figures 7 and 8 show the bias current, offset current, and gain variation over a -55°C to $+125^\circ\text{C}$ temperature range. These performance characteristics do not tell the whole story. Since the LM121 is used with an operational amplifier, the op amp characteristics must be considered for overall amplifier performance.



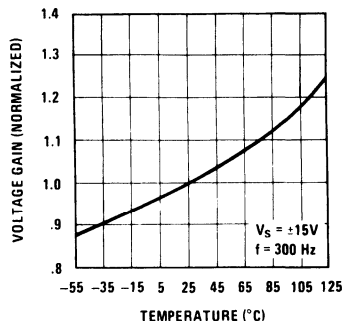
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FIGURE 6. Drift vs Offset Voltage



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FIGURE 7. Bias and Offset Current vs Temperature



TL/H/7387-8

FIGURE 8. Gain vs Temperature for the LM121

OP AMP EFFECTS

The LM121 is nominally used with a standard type of operational amplifier. The op amp functions as the second and ensuing stages of the amplifying system. When the LM121 is connected to an op amp, the two devices may be treated (and used) just as a single op amp. The inputs of the combination are the inputs of the LM121 and the output is from the op amp. Feedback, as with any op amp, is applied back to the inputs. *Figure 9* shows the general configuration of an amplifier using the LM121.

The offset voltage and drift of the op amp used have an effect on overall performance and must be considered. (The bias and offset currents of today's op amp are low enough to be ignored.) Although the exact effects of the op amp stage are difficult and tedious to calculate, a few approximations will show the sources of drift.

Op amp drift is perhaps the most important source of error. Drift of the op amp is directly reduced by the gain of the LM121. The drift referred to the input is given by:

$$\text{input drift} = \frac{\text{op amp drift}}{\text{LM121 gain}} + \text{LM121 drift.}$$

If the op amp has a drift of $10 \mu\text{V}/^\circ\text{C}$ and the LM121 is operated at a gain of $A_V = 50$, there will be a $0.2 \mu\text{V}/^\circ\text{C}$ component of the total drift due to the op amp. It is therefore important that the LM121 be operated at relatively high gain to minimize the effects of op amp drift. Lower gains for the LM121 will give proportionately less reduction in op amp drift. Of course, a moderately low drift op amp such as the LM108A eases the problem.

Op amp offset voltage also has an effect on total drift. For purpose of analysis assume the LM121 to be perfect with no offset or drift of its own. Then any offset seen when the LM121 is connected to an op amp is due to the op amp alone. The offset is equal to:

$$\text{offset voltage} = \frac{\text{op amp offset}}{\text{LM121 gain}}$$

or the offset is reduced by the gain of the LM121. For example, with a gain of 50 for the LM121, 2 mV of offset on the op amp appears as $40 \mu\text{V}$ of offset at the LM121 input. Unlike offset due to a mismatch in the LM121, this $40 \mu\text{V}$ of offset does not cause any drift. However, when the system is nulled so the offset at the input of the LM121 is zero, $40 \mu\text{V}$ of imbalance has been inserted into the LM121. The imbalance caused by nulling the offset induced by the op

amp will cause a drift of about $0.14 \mu\text{V}/^\circ\text{C}$. With the system nulled the drift due to op amp will cause a drift of about $0.15 \mu\text{V}/^\circ\text{C}$. With the system nulled the drift due to op amp offset can be expressed as:

$$\text{drift } (\mu\text{V}/^\circ\text{C}) = \frac{\text{op amp offset (mV)}}{\text{LM121 gain}} (3.6 \mu\text{V}/^\circ\text{C}).$$

In actual operation, drift due to op amp offsets will usually be better than predicted. This is because offset voltage and drift are not independent. With the LM121 there is a strong, predictable, correlation between offset and drift. Also, there is a correlation with op amps, but it is not as strong. The drift of the op amp tends to cancel the drift induced in the LM121 when the system is nulled.

In the previous example the drift due to the op amp offset was $0.15 \mu\text{V}/^\circ\text{C}$. If the op amp has a drift of $3.6 \mu\text{V}/^\circ\text{C}$ per millivolt of offset (like the LM121) it will have a drift of $7.2 \mu\text{V}/^\circ\text{C}$. This drift is reduced by the gain of the LM121 ($A_V = 50$) to $0.14 \mu\text{V}/^\circ\text{C}$. This $0.14 \mu\text{V}/^\circ\text{C}$ will cancel the $0.14 \mu\text{V}/^\circ\text{C}$ drift due to balancing the LM121. Since op amps do not always have a strong correlation between offset and drift, the cancellation of drifts is not total. Once again, high gain for the LM121 and a low offset op amp helps achieve low drifts.

FREQUENCY COMPENSATION

The additional gain of the LM121 preamplifier when used with an operational amplifier usually necessitates additional frequency compensation. This is because the additional gain introduced by the LM121 must be rolled-off before the phase shift through the LM121 and op amp reaches 180° . The additional compensation depends on the gain of the LM121 as well as the closed loop gain of the system. Two frequency compensation techniques are shown here that will operate with any op amp that is unity gain stable.

When the closed loop gain of the op amp with the LM121 is less than the gain of the LM121 alone, more compensation is needed. The worst case situation is when there is 100% feedback — such as a voltage follower or integrator — and the gain of the LM121 is high. When high closed loop gains are used — for example $A_V = 1000$ — and only an additional gain of 100 is inserted by the LM121, the frequency compensation of the op amp will usually suffice.

The basic circuit of the LM121 in *Figure 9* shows two compensation capacitors connected to the op amp (disregarding the 30 pF frequency compensation for the op

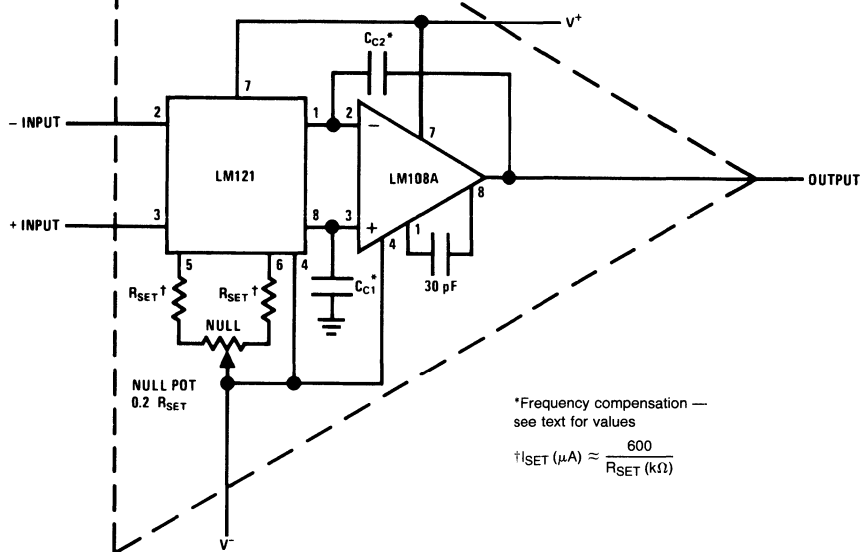


FIGURE 9. General Purpose Amplifier Using the LM121

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amp alone). The capacitor from pin 6 to pin 2 around the op amp acts as an integrating capacitor to roll off the gain. Since the output of the LM121 is differential, a second capacitor is needed to roll off pin 3 of the op amp. These capacitors are C_{C1} and C_{C2} in Figure 9.

With capacitors equal, the circuit retains good AC power supply rejection. The approximate value of the compensation capacitors is given by:

$$C_C = \frac{8}{10^6 A_{CL} R_{SET}} \text{ farads}$$

where R_{SET} is the current set resistor from each current source and where A_{CL} is closed loop gain. Table II shows typical capacitor values.

An alternate compensation scheme was developed for applications requiring more predictable and smoother roll off. This is useful where the amplifier's gain is changed over a wide range. In this case C_{C1} is made large and connected to V^+ rather than ground. The output of the LM121 is rendered single ended by a $0.01 \mu F$ bypass capacitor to V^+ . Overall frequency compensation then is achieved by an integrating capacitor around the op amp:

$$\text{Bandwidth at unity gain} \approx \frac{12}{2\pi R_{SET} C}$$

$$\text{for 0.5 MHz bandwidth } C = \frac{4}{10^6 R_{SET}}$$

TABLE II. Typical compensation capacitors for various operating currents and closed loop gains. Values given apply to LM101A, LM108, and LM741 type amplifiers.

Closed Loop Gain	Current Set Resistor				
	120 k Ω	60 k Ω	30 k Ω	12 k Ω	6 k Ω
$A_V = 1$	68 pF	130 pF	270 pF	680 pF	1300 pF
$A_V = 5$	15 pF	27 pF	50 pF	130 pF	270 pF
$A_V = 10$	10 pF	15 pF	27 pF	68 pF	130 pF
$A_V = 50$	1 pF	3 pF	5 pF	15 pF	27 pF
$A_V = 100$		1 pF	3 pF	5 pF	10 pF
$A_V = 500$			1 pF	1 pF	3 pF
$A_V = 1000$					

For use with higher frequency op amps such as the LM118 the bandwidth may be increased to about 2 MHz. If closed loop gain is greater than unity "C" may be decreased to:

$$C = \frac{4}{10^6 A_{CL} R_{SET}}$$

APPLICATIONS

No attempt will be made to include precision op amp applications as they are well covered in other literature. The previous sections detail frequency compensation and drift problems encountered in using very low drift op amps. The circuit shown in *Figure 9* will yield good results in almost any op amp application. However, it is important to choose the operating current properly. From the curves given it is relatively easy to see the effects of current changes. High currents increase gain and reduce op amp effects on drift. Bias and offset current also increase at high current. When the operating source resistance is relatively high, errors due to high bias and offset current can swamp offset voltage drift errors. Therefore, with high source impedances it may be advantageous to operate at lower currents.

Another important consideration is output common mode voltage. This is the voltage between the outputs of the LM121 and the positive power supply. Firstly, the output common mode voltage must be within the operating common mode range of the output op amp. At currents above 10 μ A there is no problems with the LM108, LM101, and LM741 type devices. Higher currents are needed for devices with more limited common mode range, such as the LM118. As the operating current is increased, the positive common mode limit for the LM121 is decreased. This is because there is more voltage drop across the internal 50k load resistors. The output common mode voltage and positive common mode limits are about equal and given by:

$$\text{Output common mode voltage positive} \approx V^+ - \left(0.6V + \frac{0.65 \times 50 \text{ k}\Omega}{R_{SET}} \right)$$

common mode limit

If it is necessary to increase the common mode output voltage (or limit), external resistors can be connected in parallel with the internal 50 k Ω resistors. This should only be done at high operating currents (80 μ A) since it reduces gain and diverts part of the input stage current from the internal bias-

ing circuitry. A reasonable value for external resistors is 50 k Ω .

The external resistors should be of high quality and low drift, such as wirewound resistors, since they will affect drift if they do not track well with temperature. A 20 ppm/ $^{\circ}$ C difference in external resistor temperature coefficient will introduce an additional 0.3 μ V/ $^{\circ}$ C drift.

An unusually simple gain of 1000 instrumentation amplifier can be made using the LM121. The amplifier has a floating, full differential, high impedance input. Linearity is better than 1%, depending upon input signal level with maximum error at maximum input. Gain stability, as shown in *Figure 10*, is about $\pm 2\%$ over a -55° C to $+125^{\circ}$ C temperature range. Finally, the amplifier has very low drift and high CMRR.

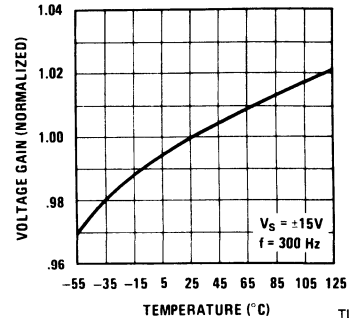


FIGURE 10. Instrumentation Amplifier Gain vs Temperature

Figure 11 shows a schematic of the instrumentation amplifier. The LM121 is used as the input stage and operated open-loop. It converts an input voltage to a differential output current at pins 1 and 8 to drive an op amp. The op amp acts as a current to voltage converter and has a single-ended output.

Resistors R_1 and R_2 with null pot R_3 set the operating current of the LM121 and provide offset adjustment. R_4 is a fine trim to set the gain at 1000. There is very little interaction between the gain and null pots.

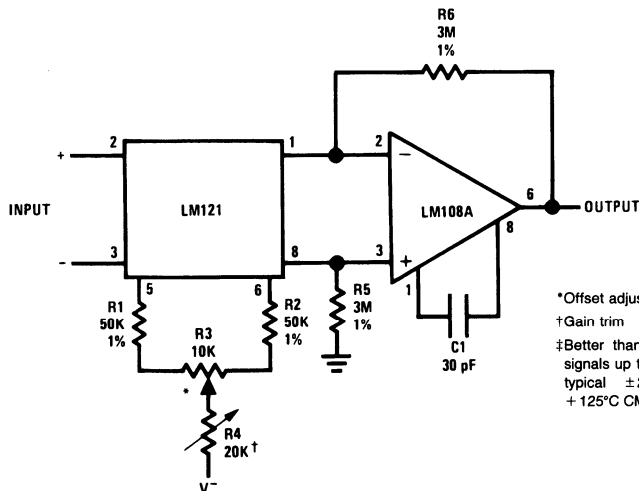


FIGURE 11. Gain of 1000 Instrumentation Amplifier

*Offset adjust

†Gain trim

‡Better than 1% linearity for input signals up to ± 10 mV gain stability typical $\pm 2\%$ from -55° C to $+125^{\circ}$ C CMRR 110 dB.

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This instrumentation amplifier is limited to a maximum input signal of ± 10 mV for good linearity. At high signal levels the transfer characteristic of the LM121 becomes rapidly non-linear, as with any differential amplifier. Therefore, it is most useful as a high gain amplifier.

Since feedback is not applied around the LM121, CMRR is not dependent on resistor matching. This eliminates the need for precisely matched resistor as with conventional instrumentation amplifiers. Although the linearity and gain stability are not as good as conventional schemes, this amplifier will find wide application where low drift and high CMRR are necessary.

A precision reference using a standard cell is shown in *Figure 12*. The low drift and low input current of the LM121A allow the reference amplifier to buffer the standard cell with high accuracy. Typical long term drift for the LM121 operat-

ing at constant temperature is less than $2 \mu\text{V}$ per 1000 hours.

To minimize temperature gradient errors, this circuit should be shielded from air currents. Good single-point wiring should also be used. When power is not applied, it is necessary to disconnect the standard cell from the input of the LM121 or it will discharge through the internal protection diodes.

CONCLUSIONS

A new preamplifier for operational amplifiers has been described. It can achieve voltage drifts as low as many chopper amplifiers without the problems associated with chopping. Operating current is programmable over a wide range so the input characteristics can be optimized for the particular application. Further, using a preamp and a conventional op amp allows more flexibility than a single low-drift op amp.

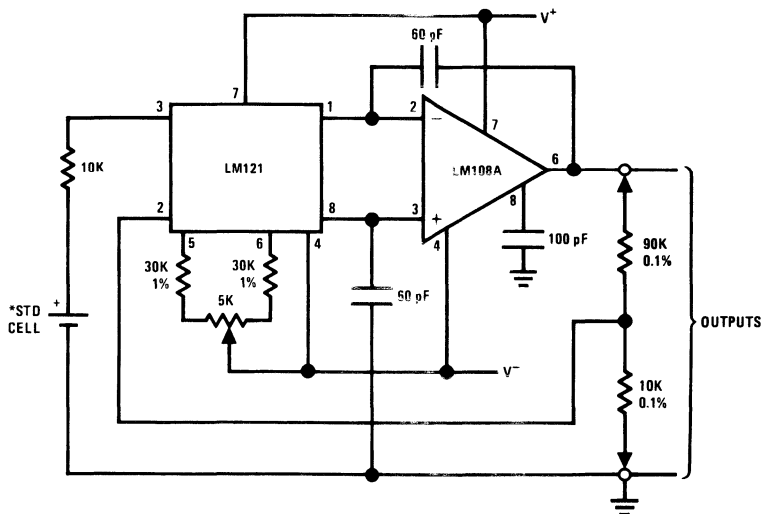


FIGURE 12. 10V Reference

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LM1800 (LM1310, LM1310E*) Phase Locked Loop FM Stereo Demodulator

National Semiconductor
Application Note 81
T.D. Isbell
D.S. Mishler



INTRODUCTION

The LM1800 is a phase locked loop FM stereo demodulator built on a single monolithic die. In addition to separating left (L) and right (R) signal information from the detected IF output, the LM1800 features automatic stereo/monaural switching, 45 dB power supply rejection, and a 100 mA stereo indicator lamp driver. Particularly attractive is the low external part count and total elimination of coils. A single inexpensive potentiometer performs all tuning. The resulting FM stereo system delivers high fidelity sound while still meeting the cost requirements of inexpensive stereo receivers.

Figures 1 and 2 outline the role played by the LM1800 in the FM stereo receiver. The frequency domain plot shows that the composite input waveform contains L + R information in the audio band and L - R information suppressed carrier modulated on 38 kHz. A 19 kHz pilot tone, locked to the 38 kHz subcarrier at the transmitter, is also included. SCA information occupies a higher band but is of no importance in the consumer FM receiver.

The block diagram of the LM1800 shows the composite input signal applied to the audio frequency amplifier, which acts as a unity gain buffer to the decoder section. A second amplified signal is capacitively coupled to two phase detectors — one in the phase locked loop and the other in the

stereo switching circuitry. In the phase locked loop, the output of the 76 kHz voltage controlled oscillator (VCO) is frequency divided twice (to 38 then 19 kHz), forming the other input to the loop phase detector. The output of the loop phase detector adjusts the VCO to precisely 76 kHz. The 38 kHz output of the first frequency divider becomes the regenerated subcarrier which demodulates L - R information in the decoder section. The amplified composite and an "in phase" 19 kHz signal, generated in the phase locked loop, drive the "in phase" phase detector. When the loop is locked, the DC output voltage of this phase detector measures pilot amplitude. For pilot signals sufficiently strong to enable good stereo reception the trigger latches, applying regenerated subcarrier to the decoder and powering the stereo indicator lamp. Hysteresis, built into the trigger, protects against erratic stereo/monaural switching and the attendant lamp flicker.

In the monaural mode (electronic switch open) the decoder outputs duplicate the composite input signal except that the de-emphasis capacitors (from pins 3 and 6 to ground) roll off with the load resistors at 2 kHz. In the stereo mode (electronic switch closed), the decoder demodulates the L - R information, matrixes it with the L + R information, then delivers buffered separated L and R signals to output pins 4 and 5 respectively.

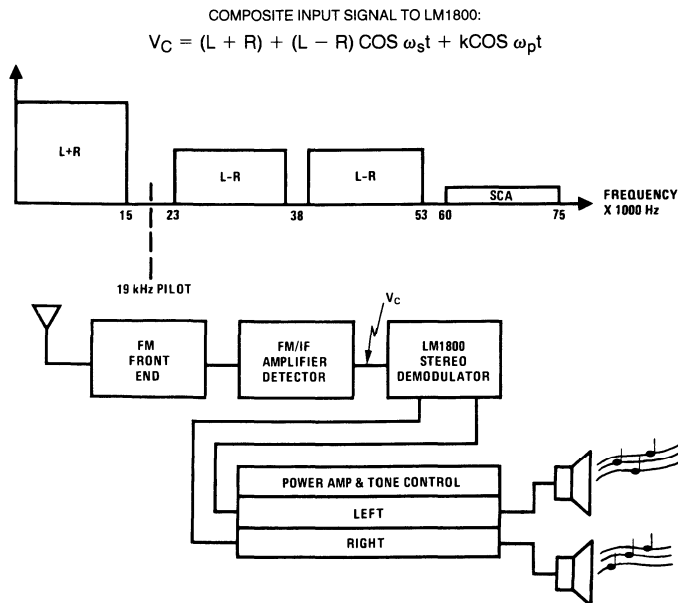


FIGURE 1. FM Receiver Block Diagram and Frequency Spectrum of LM1800 Input Signal

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*The information contained in this application note also generally applies to LM1310, LM1310E.

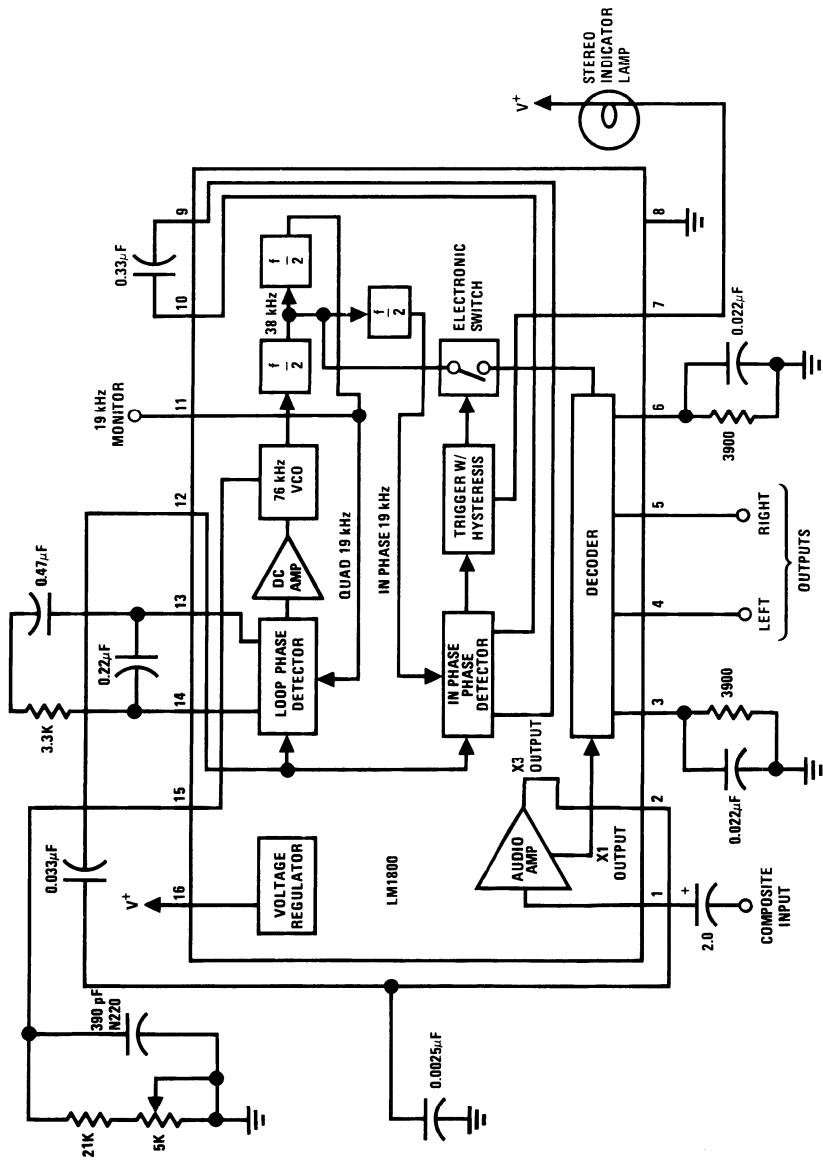
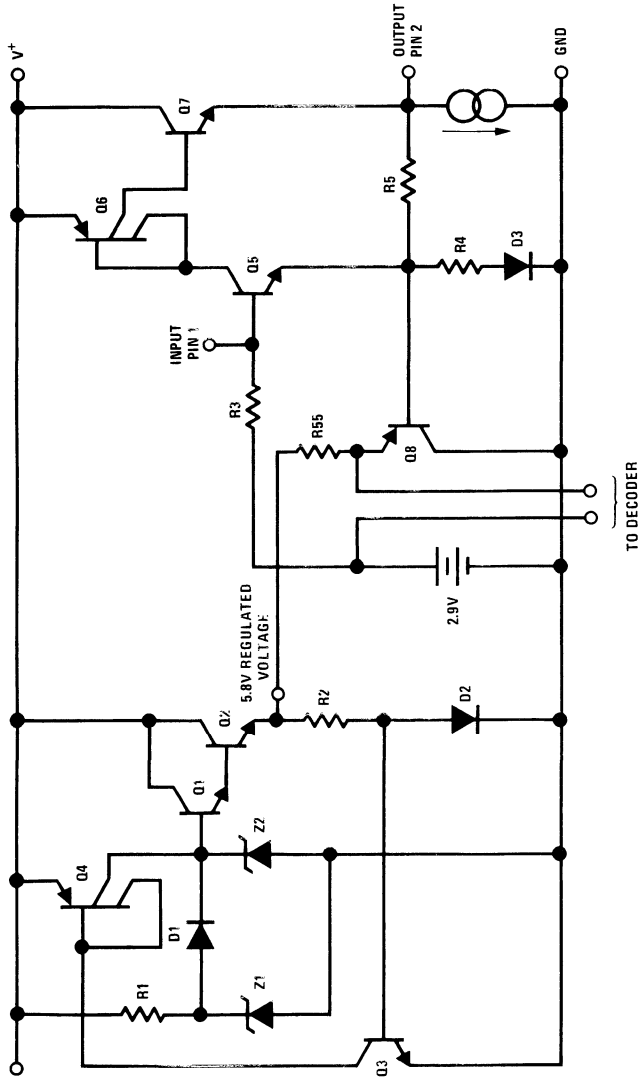


Figure 2. LM1800 Block Diagram



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Figure 3. Regulator and Audio Amplifier

CIRCUIT DESCRIPTION

The complex circuit schematic of *Figure 13* is more easily understood by reducing it to four subsections:

- Regulator and Audio Amplifier
- Phase Locked Loop
- Stereo/Monaural Switching Circuitry
- Decoder and Output Section

Regulator and Audio Amplifier

Transmission of power supply ripple and noise has plagued users of integrated FM stereo demodulators in the past. The introduction of a voltage regulator on the chip, along with improvements in the decoder output circuitry, provides excellent supply rejection, eliminating the need for costly supply filtering. *Figure 3* shows an equivalent schematic of the 5.8V regulator. Z_2 holds the voltage across R_2 constant, thereby establishing a constant current through D_2 , Q_3 and Q_4 . The current through Z_2 then depends on the voltage drop across Z_2 and not on the supply line. R_1 , Z_1 and D_1 assure startup after which the voltage across D_1 drops to zero, disconnecting R_1 from the remainder of the regulator circuitry.

The audio amp is biased internally by 2.9V through R_3 to the base of Q_5 . Since the emitter current of Q_5 is much less than that of Q_7 and the base current of Q_8 is also negligible, current through R_4 approximately equals that through R_5 . The DC quiescent voltage at the output pin becomes:

$$V_{P2} = V_{E5} + (V_{E5} - 0.7) R_5/R_4 = 5.4 \text{ volts}$$

and gain to a dynamic input is:

$$A_{\text{pin 1} - \text{pin 2}} = 1 + R_5/R_4 = 3.0$$

A second signal path of unity gain exists through Q_5 and Q_8 . The potential at Q_8 's emitter is also approximately 2.9V, providing conveniently biased drive to the decoder section. R_3 sets the input resistance at typically 45 k Ω .

Phase Locked Loop

A phase locked loop is a feedback system comprised of a phase detector, a low pass filter, and an error amplifier in the forward transmission path while a voltage controlled oscillator provides the feedback element. *Figure 4* illustrates a simplified loop. Without an input signal the error voltage drops to zero. The VCO then oscillates at some free running frequency, f_0 . As an input signal is introduced, the phase detector compares the phase (and frequency, since frequency is the time derivative of phase) of the input signal with that of the VCO, generating an error voltage related to the frequency difference. The error signal is filtered and amplified before it is applied to the control input of the VCO. The control voltage forces the VCO frequency to move in the direction that reduces the frequency difference between the input signal and f_0 . For free running frequencies sufficiently close to the incoming signal, the nature of loop feedback causes the VCO to synchronize to exactly the incoming frequency. Some finite phase difference exists between the two signals. This phase difference is necessary to generate the corrective error voltage for the VCO.

The LM1800 operates on precisely this principle except that the VCO free runs at approximately four times the frequency of the incoming pilot. Two frequency dividers provide a sig-

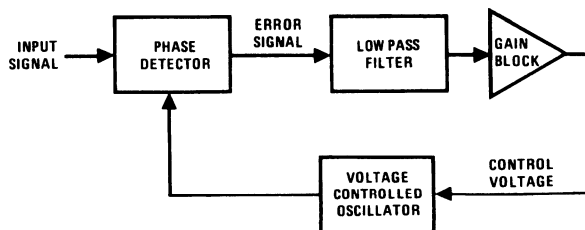


FIGURE 4. Basic Phase Locked Loop Block Diagram

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nal at the phase detector input sufficiently close in frequency to the 19 kHz pilot tone to accomplish lock. The loop provides sufficient gain to keep the phase error small, and the frequency dividers generate accurate 50% duty cycle waveforms, both necessary requirements for good stereo demodulation.

VCO

Consider the voltage controlled oscillator scheme outlined in *Figure 5*. At turn-on the non-inverting input rises rapidly to 1.2V as set by the resistor divider (R_{13}/R_{15}), while the external capacitor holds the inverting input low. The output quickly rises to 5.8V and begins charging the capacitor through R_{11} . The output simultaneously lifts the non-inverting input rapidly to 4.7V. When the voltage across the capacitor also reaches 4.7V, the output drops low, reverse biasing the diodes while the capacitor begins discharging through the potentiometer. With the output low, the non-inverting input is again resistively set at 1.2V until the capaci-

tor discharges and the cycle repeats. The capacitor voltage decays about twenty times slower than it charges, resulting in a repetition rate dominated by the external RC time constant.

When the VCO is in its high state, the output is clamped at the regulated voltage. This causes the temperature coefficient of the trip points to be dependent on only the regulated voltage, resulting in an oscillation frequency quite independent of temperature.

Figure 6 details the frequency dividers used to transform the short duty cycle 76 kHz waveform into precisely 50% duty cycle 38 and 19 kHz waveforms. To understand their operation, first consider Q_{24}/Q_{25} saturated while Q_{23}/Q_{26} are in cutoff. As the trigger goes low the collector voltage for Q_{25}/Q_{26} collapses and conduction in them ceases. Since Q_{23}/Q_{24} are bistable by themselves, Q_{24} remains saturated and Q_{23} cutoff. With the trigger in this low state, the base of Q_{24} sits at one base-emitter voltage (0.7V) while the base

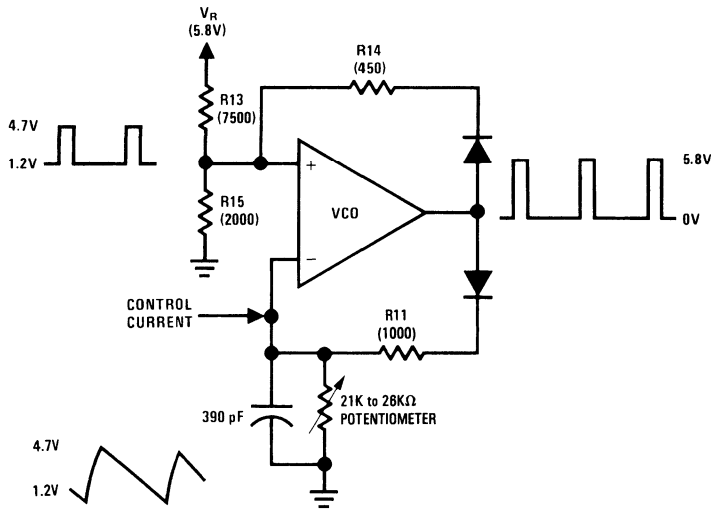
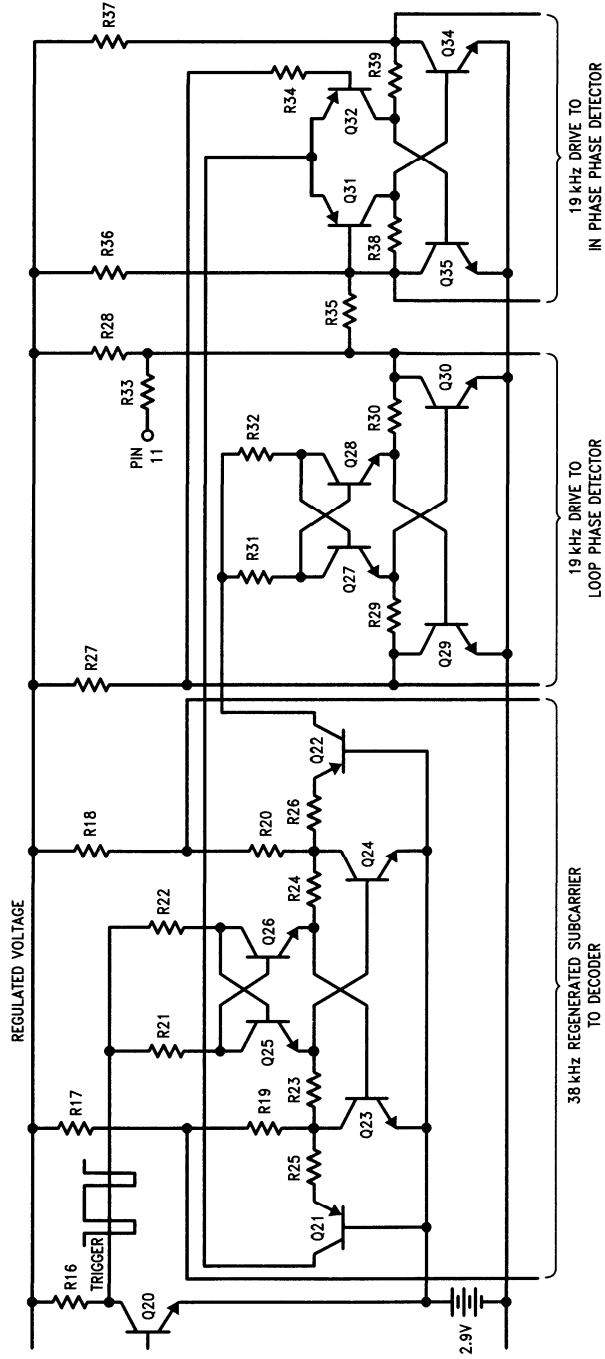


FIGURE 5. Equivalent Circuit of VCO

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FIGURE 6. Frequency Dividers

of Q_{23} is at the saturation voltage of Q_{24} (0.2V). On the rising edge of the trigger pulse, Q_{26} conducts before Q_{25} because of the different voltages on their emitters. Q_{26} saturates and drives enough current through R_{24} to saturate Q_{23} while Q_{24} goes to cutoff. Thus Q_{23}/Q_{24} change state on every rising edge of a trigger pulse, dividing the repetition rate of the trigger signal by two. The other two frequency dividers function similarly except that the third one is slaved in quadrature with the second. *Figure 7* shows the waveforms throughout the divider string.

Loop Phase Detector

The loop phase detector is shown equivalently in *Figure 8*. Consider the loop phase detector where the toggle is driven in quadrature with the pilot.

The waveforms show that zero volts DC appears across the capacitor. Any deviation from this quadrature relationship produces a voltage, which is a function of phase difference, across the capacitor. A second condition results when the toggle is driven in phase with the pilot. In this case the DC voltage across the capacitor measures pilot tone amplitude and is used to drive the stereo-monaural switching circuitry.

The DC amplifier in the phase locked loop is standard differential with push-pull output, maintaining excellent temperature stability in the loop.

Stereo/Monaural Switching Circuitry

Composite inputs sufficiently large for good quality stereo switch the LM1800 into the stereo mode via the circuitry

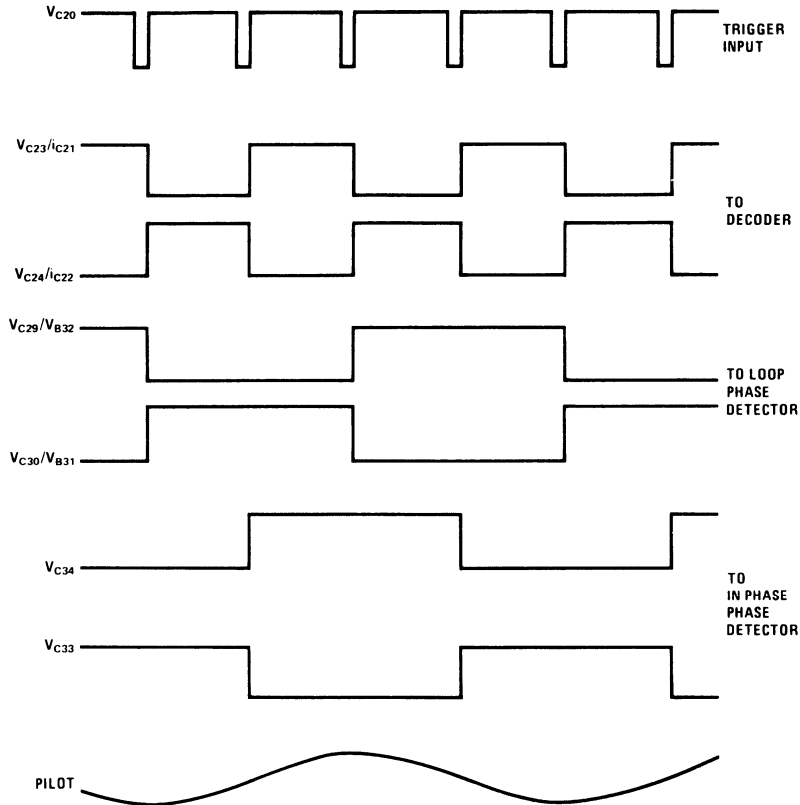


FIGURE 7. Frequency Divider Waveforms

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of Figure 9. The differential pair Q₄₇/Q₄₈ is driven by the DC output of the "in phase" phase detector. When the phase locked loop is locked, this differential input voltage to Q₄₇/Q₄₈ is proportional to pilot amplitude (as explained in previous section and Figure 8). The emitter area of Q₄₇ is five times larger than that of Q₄₈, building in 40 mV offset voltage. Until the base of Q₄₈ is 40 mV higher than the base of Q₄₇, collector current in Q₄₇ is larger than collector current in Q₄₈. Transistor design of Q₄₉ constrains its beta to unity. So long as I_{C47} is larger than I_{C48}, Q₄₉ remains in saturation (holding Q₅₀ in cutoff). When the 40 mV offset voltage is overcome in Q₄₇/Q₄₈, Q₄₉ comes out of saturation and Q₅₀ enters conduction. Q₅₀, Q₅₁, D₅, and R₅₁ form

a positive feedback loop which regenerates when Q₅₀ is allowed to conduct. R₅₁ is chosen to halt the regeneration process at I_{C51} = 30 μA. The latched loop current drives the lamp driver Darlington (Q₅₄/Q₅₅) as well as Q₅₇ (via Q₅₂ and Q₅₃). The signal to the decoder switches from common to differential mode 38 kHz and stereo demodulation begins. Should the input composite waveform decrease by 6 dB, the differential voltage back at Q₄₇/Q₄₈ reduces to 20 mV. Under this condition the current flowing from Q₄₉ into Q₅₁ (as Q₄₉ returns toward saturation) is sufficient to unlatch the loop, prohibiting drive to both Q₅₇ and Q₅₄/Q₅₅. The signal driving the decoder returns to common mode 38 kHz and monaural reception resumes. R₅₂ and Q₅₆ limit cold lamp surge currents to about 250 mA.

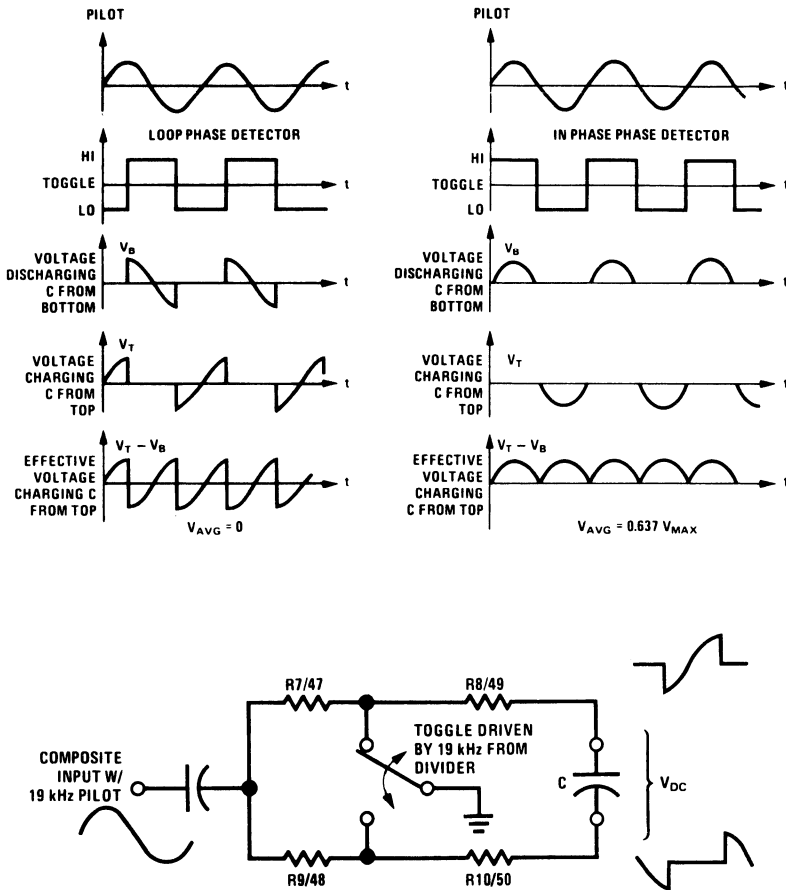
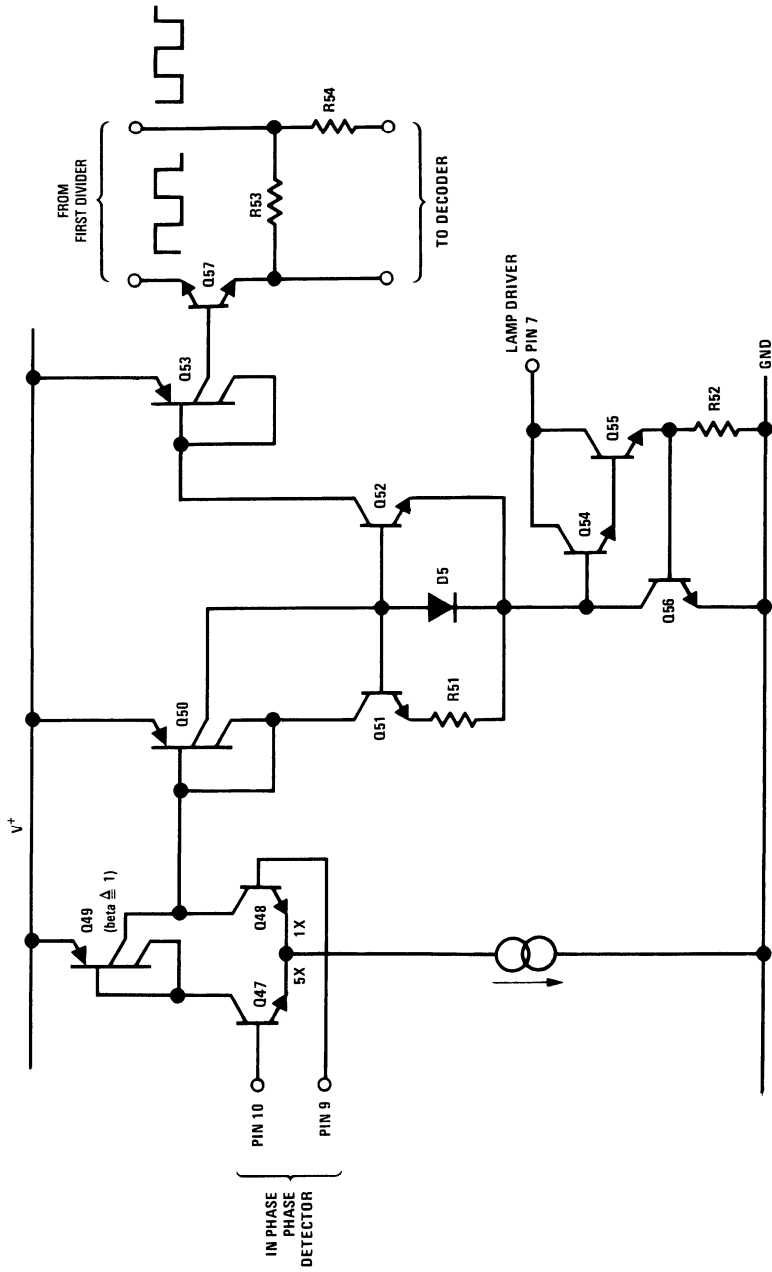


FIGURE 8. Phase Detector Performance

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Figure 9. Stereo/Monaural Switch

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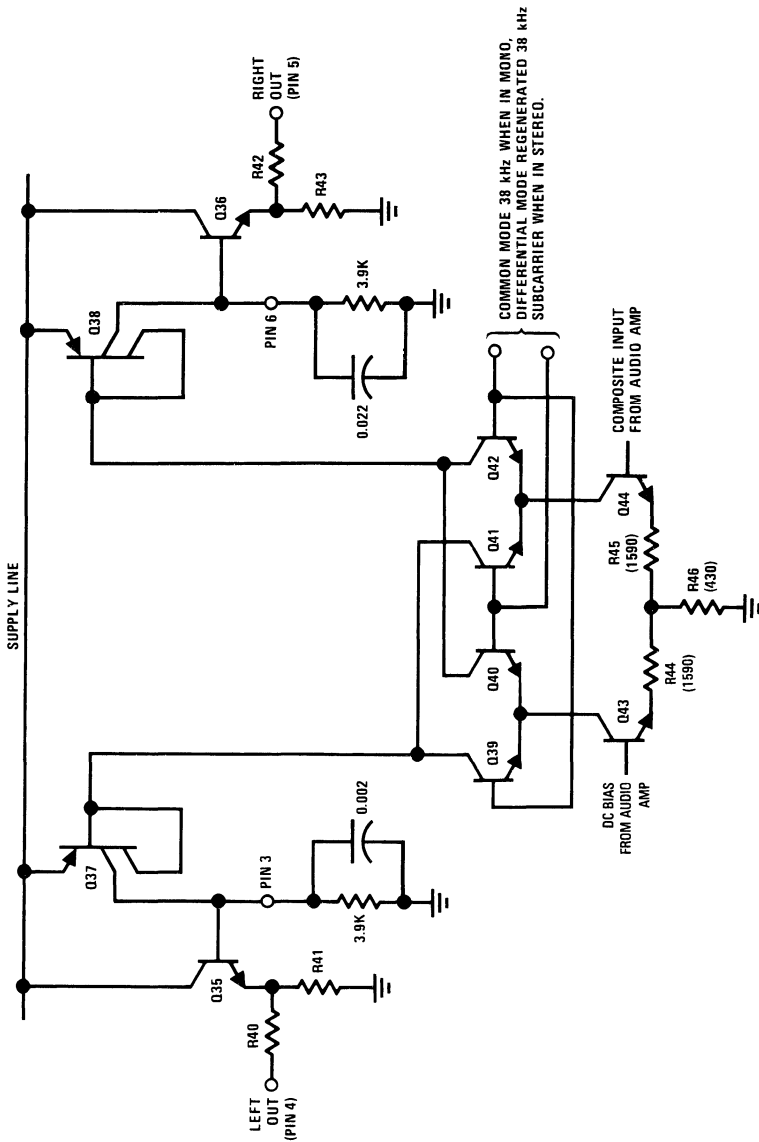


FIGURE 10. Decoder and Output Section

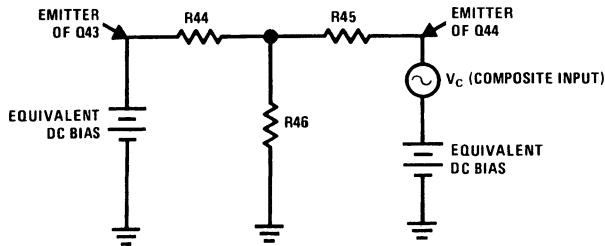


FIGURE 11. Equivalent Circuit for Decoder Matrix

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Decoder and Output Section

The basic decoder section shown in *Figure 10* has been used previously in the LM1304, LM1305, LM1307, LM1307E series, and is well described in reference 2. In an effort to transform the rigor into intuition, consider first Q_{43} , Q_{44} , and the emitter matrix resistors (R_{44} , R_{45} , R_{46}). Under small signal conditions the emitter of Q_{43} remains at a constant voltage while the emitter of Q_{44} tracks the composite input waveform applied to its base. Analysis of the simplified circuit shown in *Figure 11* produces the current waveforms through R_{44} and R_{45} . These currents are not equal and opposite as in a standard multiplier because R_{46} in no way approximates a current source. Rather, the currents through R_{44} and R_{45} can be shown to be related by a constant:

$$K = I_{R44}/I_{R45} = R_{46}/(R_{45} + R_{46})$$

For NPN transistors operating in their active regions, collector current approximately equals emitter current then:

$$I_{43} = KI_{C44}$$

Since the upper quad transistors (Q_{39} , Q_{40} , Q_{41} , Q_{42}) operate as antiphase switches, the base current resulting through Q_{38} becomes the sum of I_{C44} gated by Q_{42} and I_{C43} gated by Q_{40} . These upper quad transistors alternately pass or block the currents flowing in Q_{43} and Q_{44} . This gating action is represented mathematically in *Figure 12*. Applying the gating function to the currents in Q_{43} and Q_{44} :

$$I_{B38} = V_C \left[\frac{1}{2} - \frac{2}{\pi} \cos \omega_s t \right] - K V_C \left[\frac{1}{2} + \frac{1}{\pi} \cos \omega_s t \right]$$

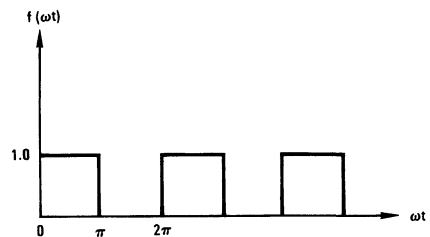
where V_C = composite input signal

and ω_s = subcarrier (38 kHz)

Substituting the expression for V_C (given in *Figure 1*), carrying out the algebra, and retaining only the low frequency terms gives:

$$I_{B38} = L \left[0.5 - 0.5K - \frac{K+1}{\pi} \right] + R \left[0.5 - 0.5K + \frac{K+1}{\pi} \right]$$

Equating the coefficient of the left (L) term to zero, yields a value for K of 0.22. Thus designing the matrix resistors, R_{44} , R_{45} , R_{46} to give this value for K cancels all left information from the Q_{38} current. The base current of Q_{38} then is proportional to the right (R) separated signal.

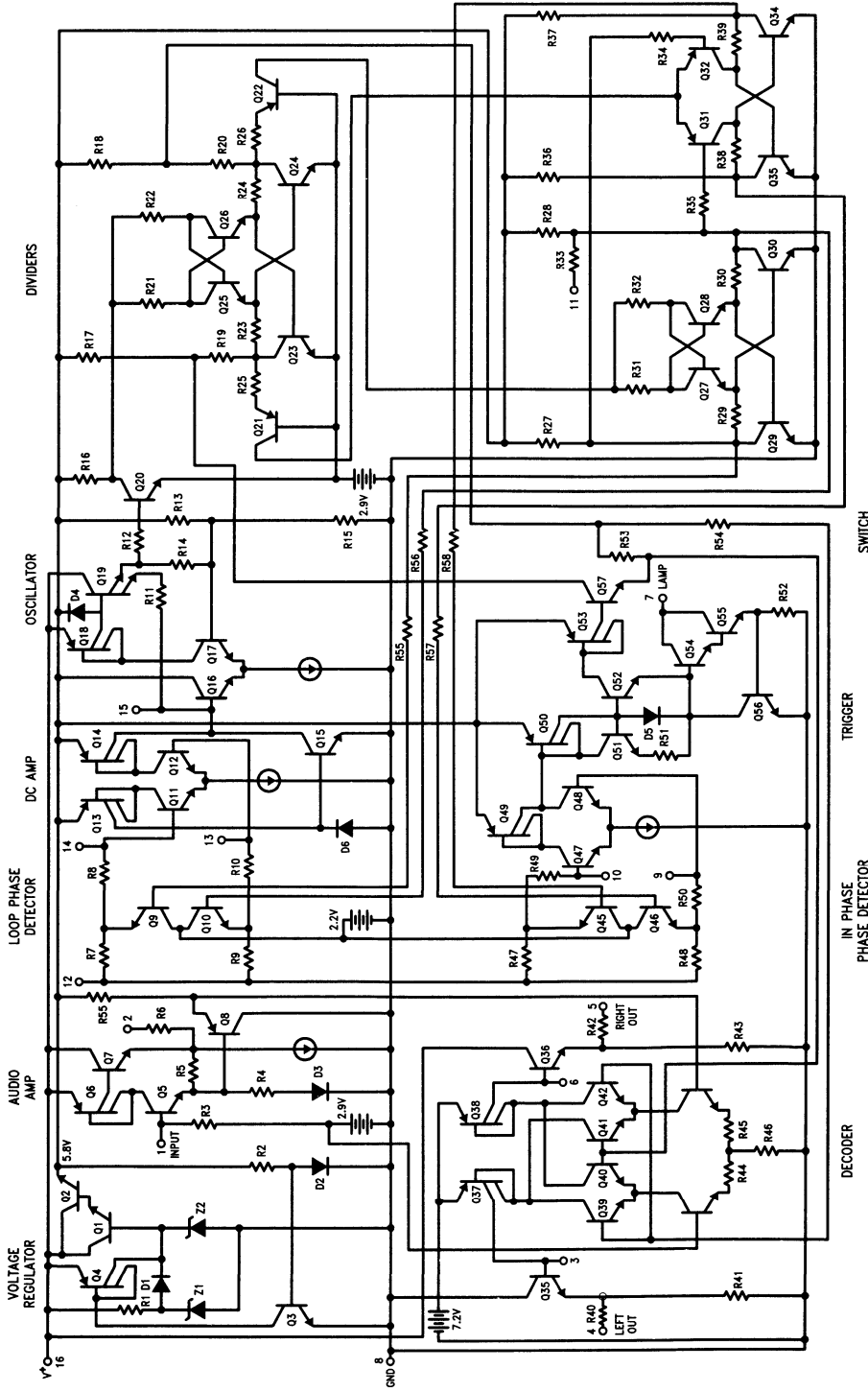


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$$\begin{aligned} f(\omega t) &= \frac{1}{2} + \frac{2}{\pi} \sum \frac{1}{n} \cos n\omega t \\ &= \frac{1}{2} + \frac{2}{\pi} \cos \omega t + \dots \end{aligned}$$

FIGURE 12. Fourier Analysis of Decoder Switching Waveform

Similar analysis can be performed to show that the base current of Q_{37} contains only left (L) separated signal. Amplification and level shifting of these base currents in fixed beta transistors Q_{37} and Q_{38} , and the resultant currents drive external grounded loads at pins 3 and 6. Since the collector currents of Q_{37} and Q_{38} depend only on their respective base currents, supply ripple and noise are rejected from the output pins. Q_{35} and Q_{36} serve as output buffers with R_{40} and R_{42} setting the output resistance at typically 1300Ω.



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FIGURE 13. LM1800 Equivalent Schematic

In the monaural mode the upper quad transistors are driven by a common mode signal which causes all four transistors to conduct equally. This passes the composite input directly to the outputs where the de-emphasis capacitors serve to roll off the higher frequency unwanted information. Further, the LM1800 offers improved distortion over earlier integrated demodulators. As the signal driving the base of Q_{44} increases in amplitude, the AC currents through Q_{43} and Q_{44} become a significant percentage of the DC bias currents. In this manner the transconductance of Q_{43} and Q_{44} is modulated by the incoming signal resulting in second harmonic distortion. To reduce this effect, the base bias potentials of Q_{43} and Q_{44} and the matrix resistor values have been raised above the levels used in earlier demodulators. The loss in gain that this implies is recovered in the PNP level shifting transistors.

CIRCUIT PERFORMANCE

The circuit in *Figure 14* illustrates the simplicity of designing an FM stereo demodulation system using the LM1800. R_3 and C_3 establish an adequate loop capture range and a low frequency well damped natural loop resonance. C_8 has the effect of shunting phase jitter, a dominant cause of high frequency channel separation problems. Recall that the 38 kHz subcarrier regenerates by phase locking the output of a 19 kHz divider to the pilot tone. Time delays through the divider result in the 38 kHz waveform leading the transmitted subcarrier. Addition of capacitor C_9 (0.0025 μ F) at pin 9 introduces a lag at the input to the phase lock loop, compensating for these frequency divider delays. The output resistance of the audio amplifier is designed at 500 Ω to facilitate this connection.

Table 1 and *Figures 15* through *27* detail typical performance resulting from this basic hookup. The excellent supply rejection characteristics shown, coupled with the fact that supply current drain is nearly independent of supply voltage, somewhat simplifies receiver power supply requirements. The low drain current, even for a 24V supply, results in cool-

er circuit operation and increased reliability. *Figure 22* shows that increasing the size of input coupling capacitor C_6 improves low frequency channel separation by reducing the phase shift of the lower frequency components in the composite waveform.

Figure 27 illustrates an interesting characteristic of the LM1800: channel separation increases as the VCO is detuned in either direction. The separation peaks change in size for different signal frequencies and change in position (% detuning) for changing composite amplitudes. If the VCO free running frequency is set at precisely 19 kHz, separation remains constant over a wide range of composite amplitude levels, signal frequencies, temperature changes, and component drifts. The 19 kHz monitor available to the customer at pin 11 can be fed into a frequency counter for accurate adjustment of the VCO free running frequency. If a frequency counter is not available, the VCO can be adjusted by utilizing the fact that capture range is symmetrical about the incoming pilot:

- (a) rotate frequency adjust pot full CCW
- (b) insert weak composite input signal
- (c) rotate pot CW until stereo lamp comes on, note position of pot (R_x)
- (d) remove composite and rotate pot full CW
- (e) reinsert weak composite input signal
- (f) rotate pot CCW until stereo lamp comes on again, note position of pot (R_y)
- (g) set pot midway between R_x and R_y .

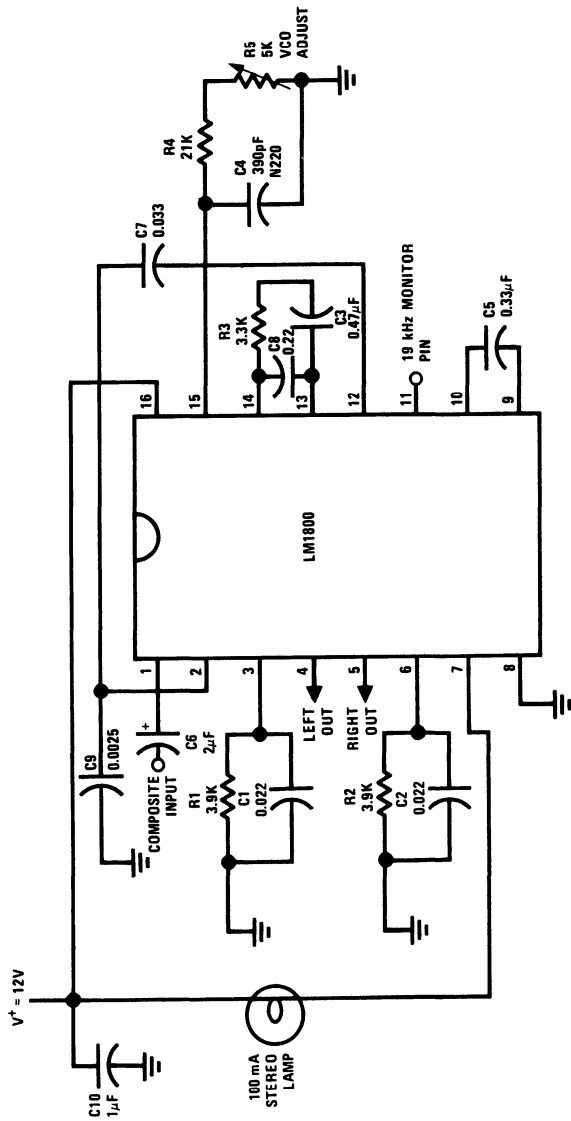
Figure 28 is included for the user who is willing to sacrifice some performance, particularly channel separation at high input levels and low frequencies to eliminate two external capacitors and reduce the electrolytic input coupling cap size.

On either circuit, some improvement in channel separation can be attained by altering the VCO.

TABLE I.

Parameters	Conditions	Type	Units
Supply Current	Lamp "OFF"	21	mA
Lamp Driver Saturation Voltage	100 mA Lamp Current	1.3	V
Lamp Driver Leakage Current		1	nA
Pilot Level for Lamp "ON"	Pin 11 Adjusted for 19 kHz \pm 10 Hz	16	mV
Pilot Level for Lamp "OFF"	Pin 11 Adjusted for 19 kHz \pm 10 Hz	8	mV
Stereo Lamp Hysteresis		6	dB
Stereo Channel Separation	100 Hz (Note 1)	40	dB
	1000 Hz (Note 1)	45	dB
	10000 Hz (Note 1)	45	dB
Monaural Channel Unbalance	200 mVrms, 1000 Hz Input	0.3	dB
Recovered Audio	200 mVrms, 400 Hz Input	190	mVrms
Total Harmonic Distortion	500 mVrms, 1000 Hz Monaural Input	0.5	%
Capture Range	25 mV of 19 kHz pilot	\pm 4	% of f_0
Supply Ripple Rejection	600 mVrms, 200 Hz Ripple	45	dB
Dynamic Input Resistance		45	k Ω
Dynamic Output Resistance		1300	Ω
SCA Rejection	200 mVrms Composite at 67 kHz	50	dB
Ultrasonic Frequency Rejection	Combined 19 and 38 kHz	33	dB

Note 1: The stereo input signal is made by summing 123 mVrms left or right modulated signal with 25 mVrms of 19 kHz pilot tone, measuring all voltage with an average responding meter calibrated in rms, the resulting waveform is about 800 mVp-p. VCO adjusted to 19kHz \pm 10Hz.



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Top View
 FIGURE 14. Typical Application Circuit

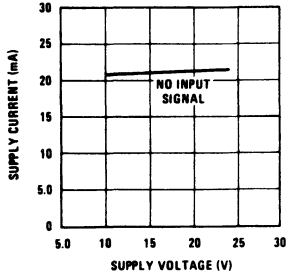


FIGURE 15. Supply Drain

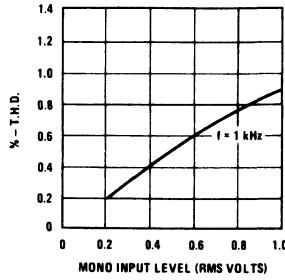


FIGURE 16. Total Harmonic

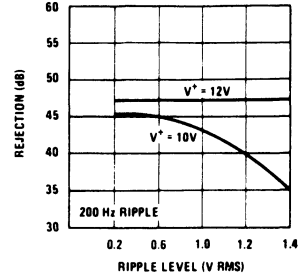


FIGURE 17. Supply Ripple Rejection

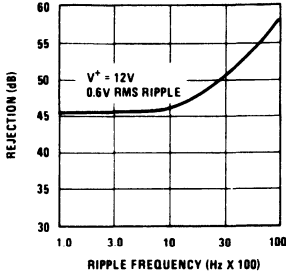


FIGURE 18. Supply Ripple Rejection

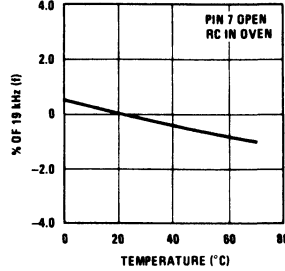


FIGURE 19. VCO Temperature Stability

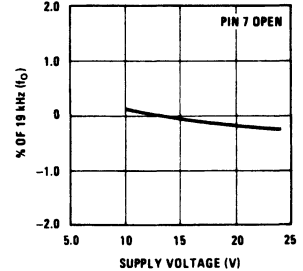


FIGURE 20. VCO Supply Sensitivity

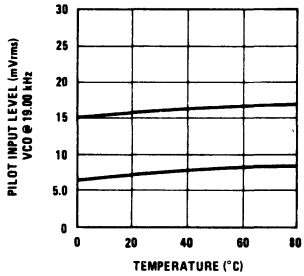


FIGURE 21. Pilot Level For Lamp On

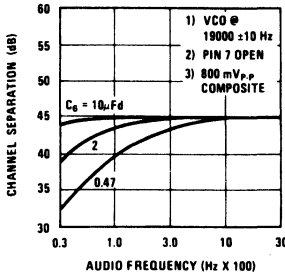


FIGURE 22. Channel Separation

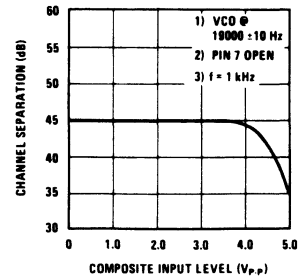


FIGURE 23. Channel Separation

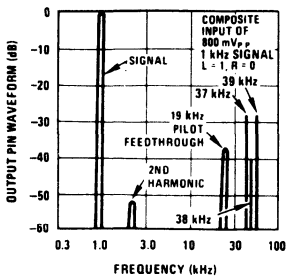


FIGURE 24. Output Frequency Spectrum

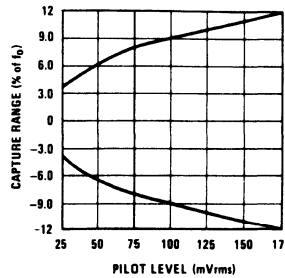


FIGURE 25. Capture Range

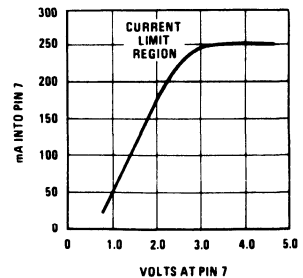
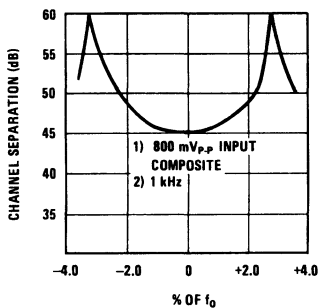


FIGURE 26. Lamp Driver Characteristics

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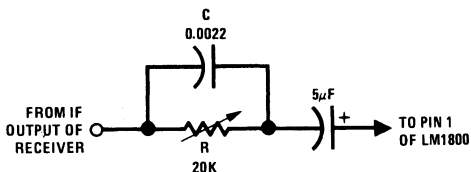


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FIGURE 27. Channel Separation and VCO Tuning

slightly. The loop gain can be shown to decrease for a decrease in VCO resistance ($R_4 + R_5$ in *Figure 14*). Maintaining a constant RC product, while increasing the capacity from 390 pF to 510 pF narrows the capture range by about 25%. Although the resulting system has slightly improved channel separation, it is more sensitive to VCO tuning.

When the circuits so far described are connected in an actual FM receiver, channel separation often suffers due to imperfect frequency response of the IF stage. The input lead network of *Figure 29* can be used to compensate for the roll off in the IF and will restore high quality stereo sound. Should a receiver designer prefer a stereo/monaural switching point different than those programmed into the LM1800 (pilot: 16 mVrms on, 8.0 mVrms off typical), the circuit of *Figure 30* provides the desired flexibility.

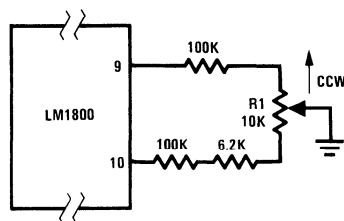
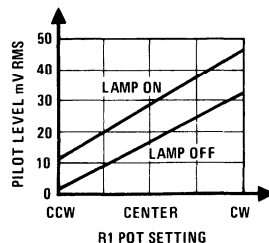


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FIGURE 29. Compensation for Receiver IF Roll-off

The user who wants slightly increased voltage gain through the demodulator can increase the size of the load resistors (R_1 and R_2 of *Figure 14* or *28*), being sure to correspondingly change the de-emphasis capacitors (C_1 and C_2). Loads as high as 5600 Ω may be used (gain of 1.4). Performance of the LM1800 is virtually independent of the supply voltage used (from 10 to 24V) due to the on chip regulator.

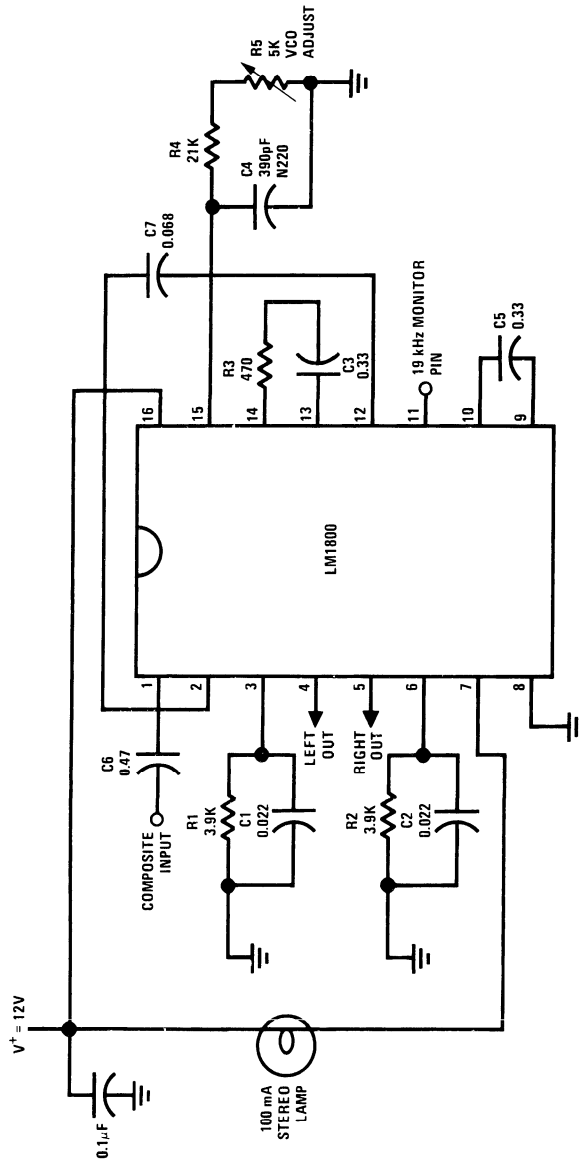
Although the circuit diagrams show a 100 mA indicator lamp, the user may desire an LED. This presents no problem for the LM1800 so long as a resistor is connected in series to limit current to a safe value for the LED. The lamp or LED can be powered from any source (up to 24V), and need not necessarily be driven from the same supply as the LM1800.



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FIGURE 30. Stereo/Monaural Switch Point Adjustment

Utilization of the phase locked loop principle enables the LM1800 to demodulate FM stereo signals without the use of troublesome and expensive coils. The numerous features available on the demodulator make it extremely attractive in a variety of home and automotive receivers. Indeed the LM1800 represents a new generation in integrated stereo FM demodulators.

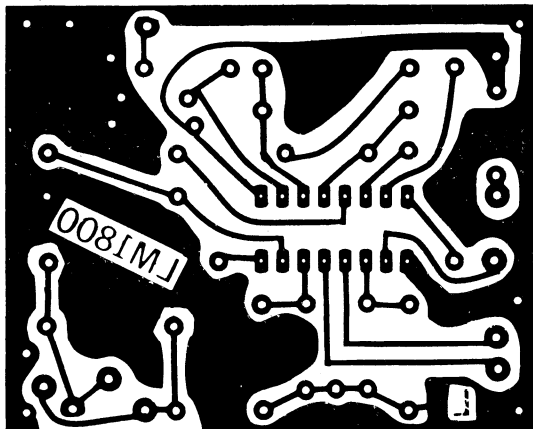


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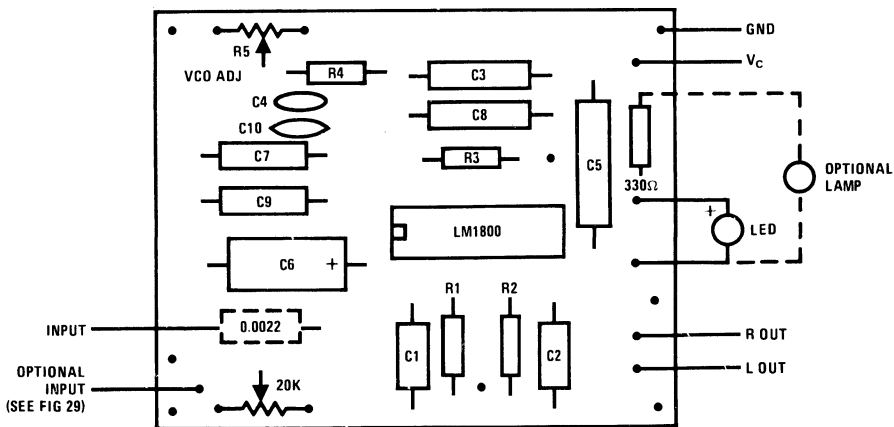
Top View
 FIGURE 28. Minimum Parts Count Application Circuit

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Printed Circuit Board Layout for Circuit of Figure 14.

TL/H/7389-20

LM125/LM126 Precision Dual Tracking Regulators

National Semiconductor
Application Note 82



INTRODUCTION

The LM125 and LM126 family of devices are precision, dual, tracking, monolithic voltage regulators. Each provides separate positive and negative regulated outputs, thus simplifying dual power supply designs. Operation requires few or no external components depending on the application. Internal settings provide fixed output voltages: the LM125 at $\pm 15V$ and the LM126 at $\pm 12V$.

Each regulator is protected from excessive internal power dissipation by a thermal shutdown circuit which turns off the regulator whenever the chip reaches a preset maximum temperature. Other features include both internal and external current limit sensing for device protection while operating with or without external current boost. For applications requiring more current than the internal current limit will allow, boosted operation is possible with the addition of a one NPN pass transistor per regulator. External resistors sense load current for controlling the limiting circuitry. Internal frequency compensation is provided on both positive and negative regulators. The internal voltage reference pins is brought out to facilitate noise filtering when desired.

CIRCUIT DESCRIPTION

Figure 1 shows a block diagram of the basic dual tracking regulator. A voltage reference establishes a fixed dc level, independent of supply or temperature variations, at the non-inverting input to the negative regulator Error Amplifier. The Error Amplifier drives the Output Control Circuit which includes the high current output transistors, current limiting, and thermal shutdown circuitry.

The negative regulator output voltage is established by comparing the Voltage Reference against a fraction of the output as set by R_A and R_B . To achieve the desired tracking action of the positive regulator, a voltage established between the positive and negative regulator outputs by resistors R_C and R_D is compared to ground by the positive regulator Error Amplifier. This insures that the positive regulator output voltage will always equal the negative regulator output voltage multiplied by the ratio of R_C to R_D . This ratio is unity for the LM125 ($V_O = \pm 15V$), and LM126 ($V_O = \pm 12V$). The positive regulator Output Control Circuit is essentially the same as that in the negative regulator.

The current limit and thermal shutdown circuitry sense the output load current and die temperature respectively and

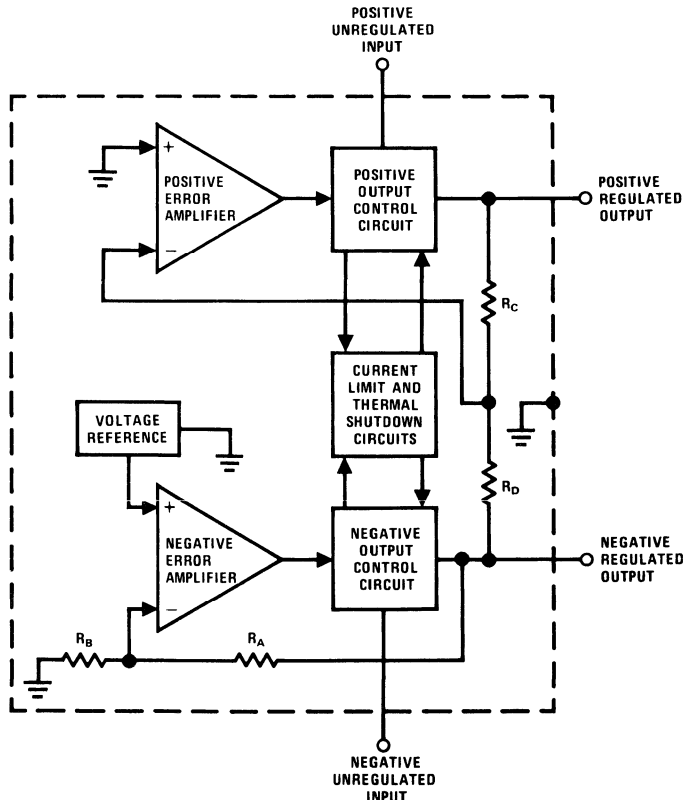


FIGURE 1. Block Diagram for the Basic Dual Tracking Regulator

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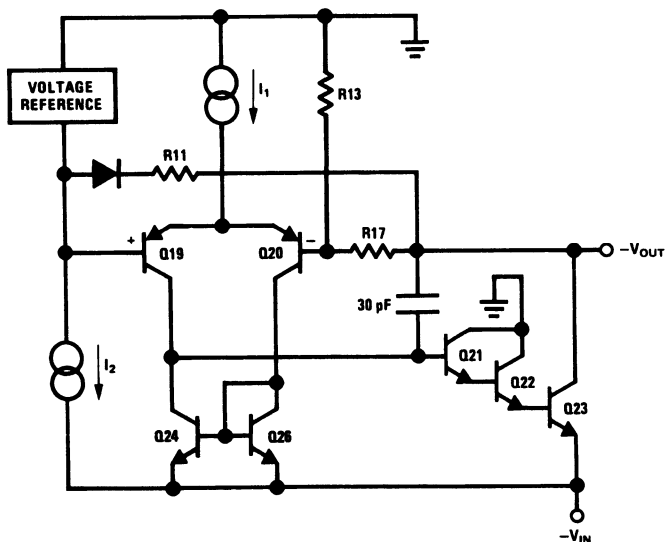


FIGURE 2. Simplified Negative Regulator

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switch off all output drive capability upon reaching their pre-determined limits.

Figure 2 gives a more detailed picture of the negative regulator circuitry. The temperature compensated reference voltage appears at the non-inverting input of the differential amplifier, Q19 and Q20, while an error signal proportional

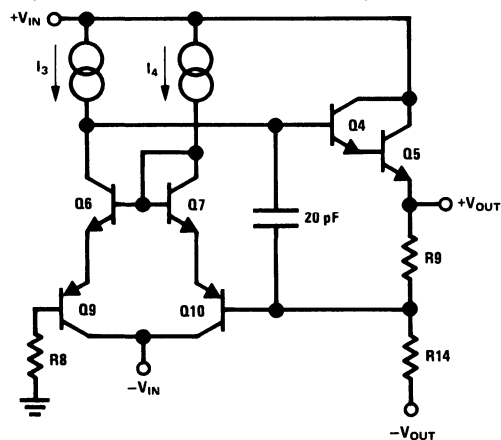


FIGURE 3. Simplified Positive Regulator

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to any change in output voltage is applied to the other input. This error signal is amplified by the differential amplifier, Q19 and Q20, and by the triple Darlington Q21, Q22, Q23 to produce a current change through R13 and R17 which brings the output voltage back to its original value. Loop gain is high, typically 88 dB at low output currents, so a 30 pF compensating capacitor is used to guarantee stability. Since $-V_{OUT}$ is the output of a high gain feedback amplifier, high supply rejection is ensured.

Figure 3 shows the basic positive regulator. This is actually an inverting operational amplifier. The negative regulated voltage ($-V_{OUT}$) is applied to the current summing input through R14 while the output ($+V_{OUT}$) is fed-back via R9. Then $+V_{OUT}$ is simply $-(R9/R14)(-V_{OUT})$. Any change

in the positive regulator output will create an error signal at the base of Q10 which will be amplified and sent to the voltage follower, Q4 and Q5, forcing the output voltage to track the input voltage. Here the loop gain is on the order of 66 dB so a compensating capacitor of approximately 20 pF is used to ensure amplifier stability.

The circuitry used for regulator start up, biasing, temperature sensing, and thermal shutdown is shown in Figure 4. The field effect transistor Q28, is initially ON allowing the negative input voltage to force current through zener diode Q34. When enough current flows to fully establish the zener voltage, transistor Q29, Q30 and Q31 turn on and bias up all current sources. The zener voltage also decreases the gate to source voltage of the FET, pinching it off to a lower current value to reduce quiescent power dissipation.

The thermal sensing and shutdown circuitry is comprised of Q34, Q29, Q35, Q32, Q37, Q38, R27, R29, R30, R31, and R33. The voltage divider made up of R29 and R30 provides a relatively fixed bias voltage V_1 at the bases of Q35 and Q36, holding them in the OFF state. When the chip temperature increases to a maximum permissible level, the base to emitter voltage of Q35 and/or Q36 will have decreased sufficiently so that V_1 is now high enough to turn them ON. This causes a voltage drop across R27 sufficient to turn on Q32 which switches Q37 and Q38 to a conducting state shunting all output drive current to $-V_{IN}$. The regulator output voltages are then clamped to zero. Transistors Q35 and Q36 are located on the chip near the regulator output devices so they will see the maximum temperatures reached on the chip, ensuring that neither regulator will ever see more than this preset maximum temperature. The collectors of Q35 and Q36 are tied together so that if either regulator reaches the thermal shutdown temperature, both regulators will shutdown. This ensures that the device can never be destroyed because of excessive internal power dissipation in either regulator.

Figure 5 shows the current limiting circuitry used in the positive regulator; the negative regulator current limiter is identical. The internal current limiter is comprised of Q8 and R5; the external current limiter is comprised of Q11 and an external resistor R_{CL} . Both operate in a similar manner. As the

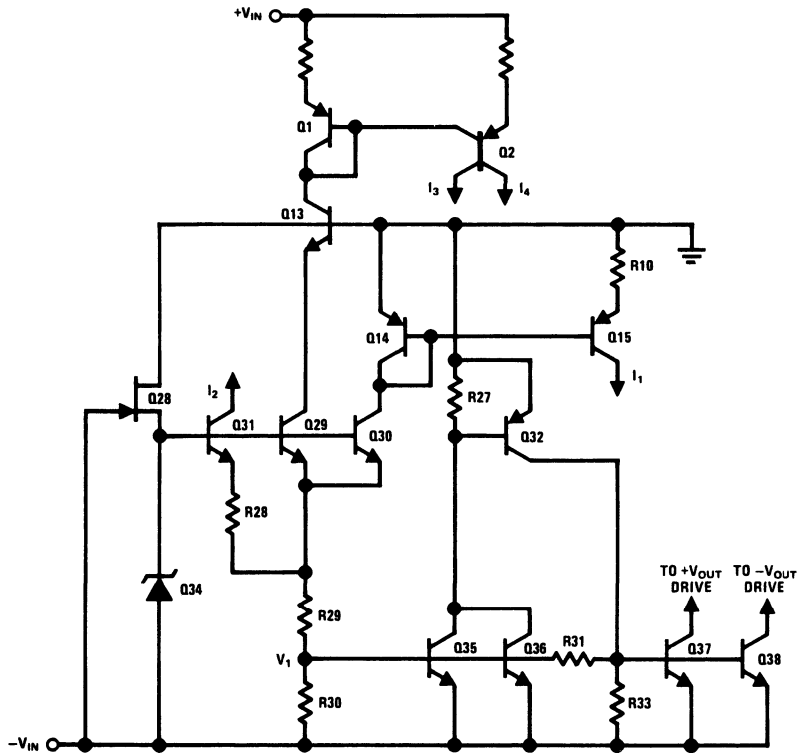


FIGURE 4. Start-up, Biasing and Thermal Shutdown Circuitry

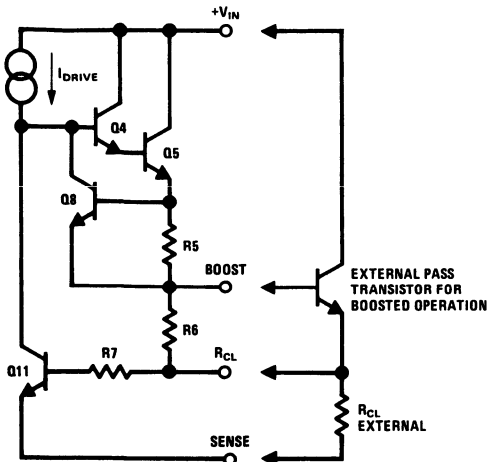
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output current through Q5 increases, the voltage drop across resistor R5 eventually turns ON Q8 and shunts all base drive away from the output devices, Q4 and Q5. The maximum load current available with this circuit is approximately 250 mA at $T_j = 25^\circ\text{C}$ (see Figure 9).

The external current limiting circuit works in a similar manner. Here the output current is sensed across the external resistor R_{CL} . When the voltage drop across R_{CL} is sufficient to turn ON transistor Q11, the output drive current is

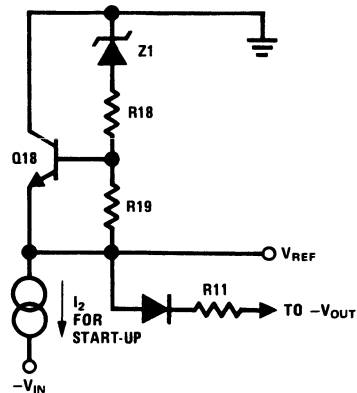
switched away from the output devices Q4 and Q5. This externally set current limit is particularly valuable when used with an external current boosting pass transistor where the current limit could be set to protect that transistor from excessive power dissipation.

The constant voltage reference circuit is shown in Figure 6. Zener diode Z1 has a positive temperature coefficient of known value. V_{BE} of Q18 (negative temperature coefficient) is multiplied by the ratio of R18 and R19 and added to the positive TC of Z1 to produce a near zero TC voltage reference. Current source I_2 is used only during start-up.



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FIGURE 5. Positive Regulator Current Limiting Circuitry



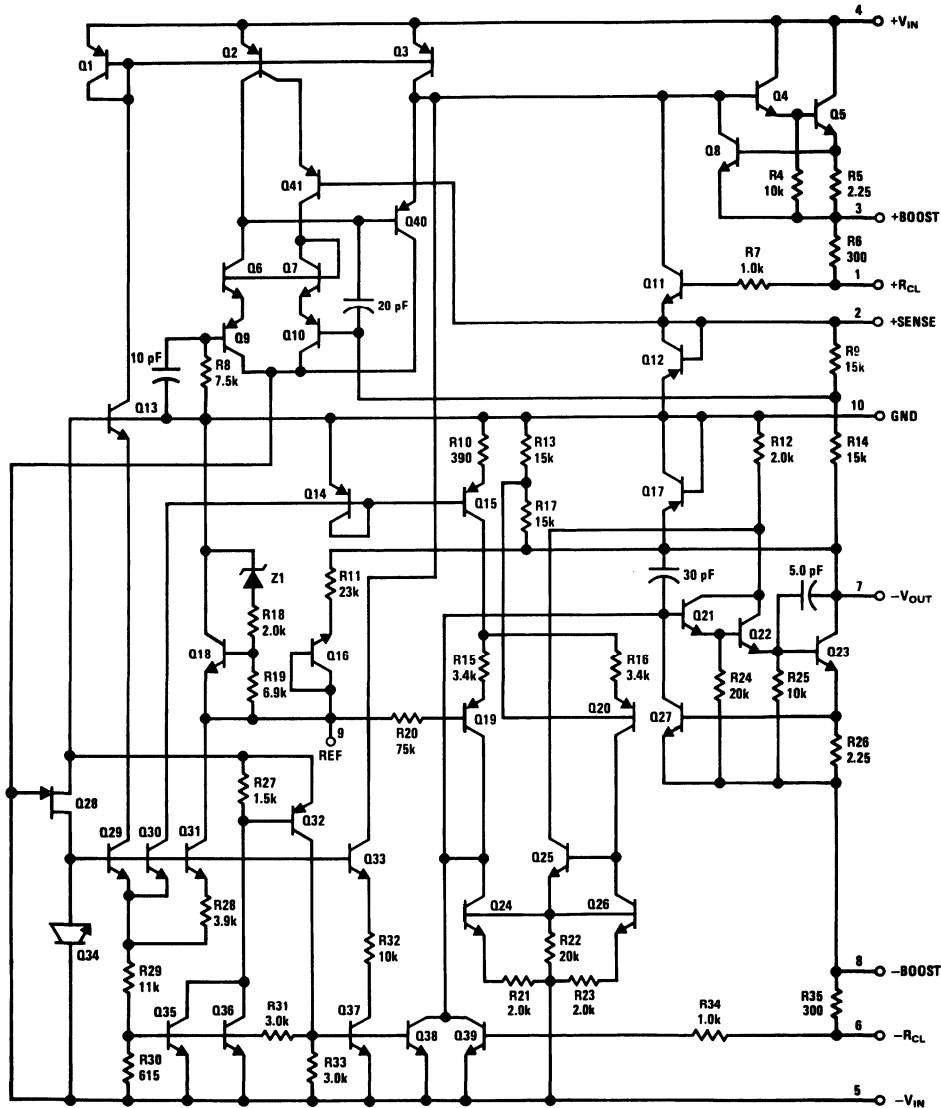
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FIGURE 6. Voltage Reference Circuitry

Figure 7 shows the complete schematic of the LM125, LM126 family of dual regulators. Diodes Q12 and Q17 protect the output transistors, plus any external pass devices used, from breakdown in the event the positive and negative regulated outputs become shorted. Transistors Q6 and Q7 offer full differential voltage gain with the convenience of single ended output. Transistors Q13 and Q33 insure that operation with $\pm 30V$ input is possible. Q24 and Q26 in the negative regulator amplifier provide single ended output from a differential input with no loss in gain.

APPLICATIONS

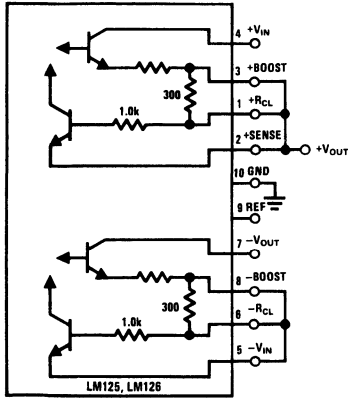
The basic dual regulator is shown connected in Figure 8. The only connections required other than plus and minus inputs, outputs, and ground are to complete the output current paths from $+R_{CL}$ to $+V_{OUT}$ and from $-R_{CL}$ to $-V_{IN}$. These may be a direct shorts if the internal preset current limit is desired, or resistors may be used to set the maximum current at some level less than the internal current limit. The internal 300Ω resistors from pins 3 to 1 and pins 8 to 6 should be shorted as shown when no external pass transistors are used. To improve line ripple rejection and transient response, filter capacitors may be added to the inputs, out-



Note: Pin numbers apply to metal can package only.

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FIGURE 7. LM125, LM126



Note: Pin numbers for metal can package only.

FIGURE 8. Basic Dual Regulator

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puts, or both, depending on the unregulated input available. If a very low noise output voltage is desired, a capacitor may be connected from the reference voltage pin to ground. Thus shunting noise generated by the reference zener. Figure 9 shows the internal current limiting characteristics for the basic regulator circuit of Figure 8.

HIGH CURRENT REGULATOR

For applications requiring more supply current than can be delivered by the basic regulator, an external NPN pass transistor may be added to each regulator. This will increase the maximum output current by a factor of the external transistor beta. The circuit for current boosted operation is shown in Figure 10.

In the boosted mode, current limiting is often a necessary requirement to insure that the external pass device is not overheated or destroyed. Experience shows this to be the usual cause of IC regulator failure. If the regulator output is grounded the pass device may fail and short, destroying the regulator. To limit the maximum output current, a series resistor (R_{CL} in Figure 10) is used to sense load current. The regulator will current limit when the voltage drop across R_{CL}

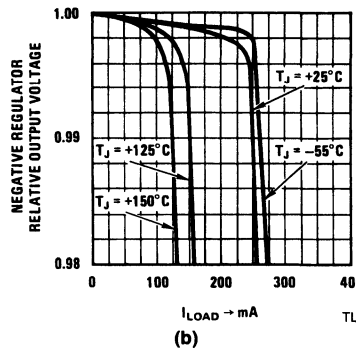
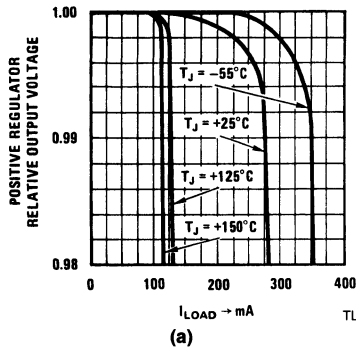


FIGURE 9. Internal Current Limiting Characteristics

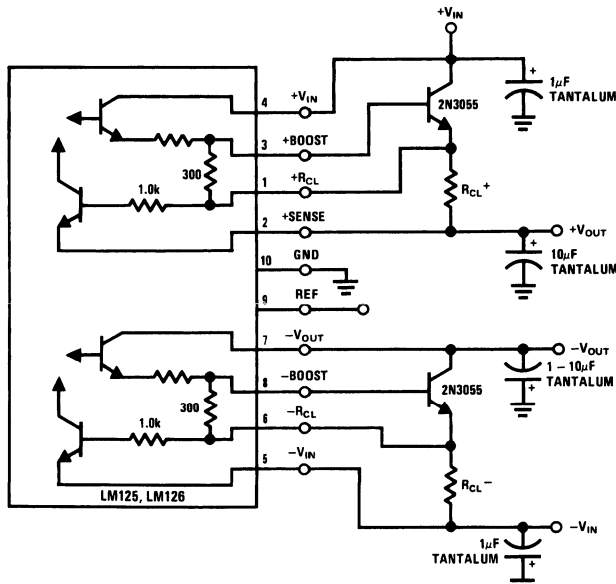
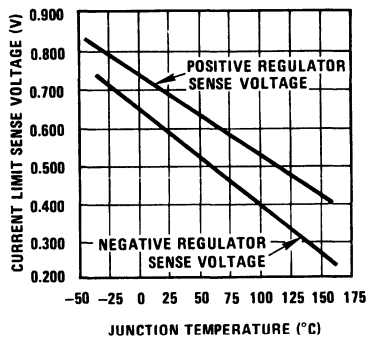


FIGURE 10. Boosted High Current Regulator

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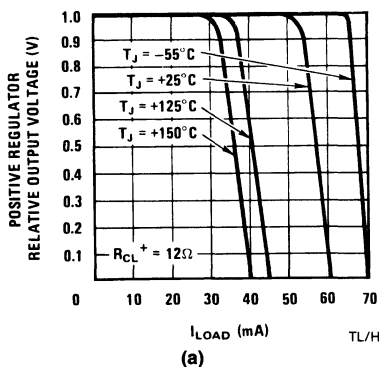
equals the current limit sense voltage found in *Figure 11*. *Figure 12* shows the external current limiting characteristics unboosted and *Figure 13* shows the external current limiting characteristics in the boosted mode.

To ensure circuit stability at high currents in this configuration, it may be necessary to bypass each input with low inductance, tantalum capacitors to prevent forming resonant circuits with long input leads. A $C \geq 1 \mu\text{F}$ is recommended. The same problem can also occur at the regulator output where a $C \geq 10 \mu\text{F}$ tantalum will ensure stability and increase ripple rejection.



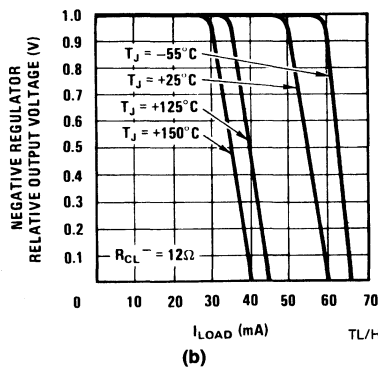
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FIGURE 11. Current Limit Sense Voltage for a 0.1% Change in Regulated Output Voltage



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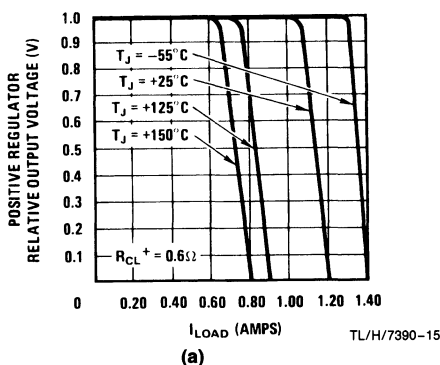
(a)



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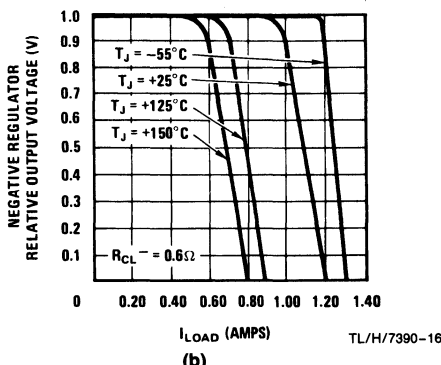
(b)

FIGURE 12. External Current Limiting Characteristics-Unboosted



TL/H/7390-15

(a)



TL/H/7390-16

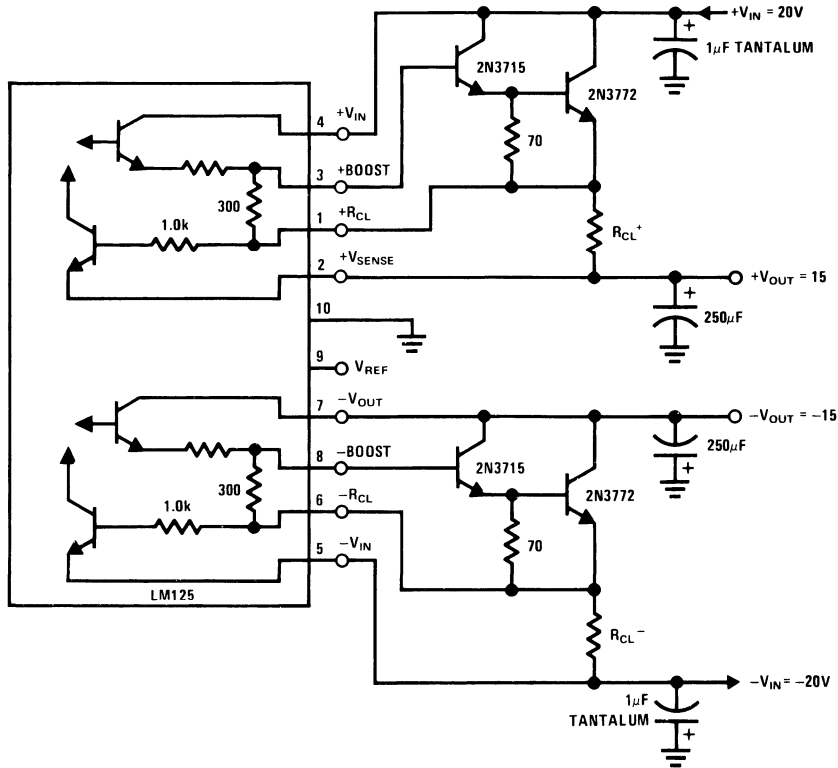
(b)

FIGURE 13. External Current Limiting Characteristics-Boosted

The 2N3055 pass device is low in cost and maintains a reasonably high beta at collector currents up to several amps. The devices 2N3055 may be of either planar or alloy junction construction. The planar devices, have a high f_T providing more stable operation due to low phase shift. The alloy devices, with f_T typically less than 1.0 MHz, may require additional compensation to guarantee stability. The simplest of compensation for the slower devices is to use output filter capacitor values greater than 50 μF (tantalum). An alternative is to use an RC filter to create a leading phase response to cancel some of the phase lag of the devices. The stability problem with slower pass transistors, if it occurs at all, is usually seen only on the negative regulator. This is because the positive regulator output stage is a conventional Darlington while the negative output stage contains three devices in a modified triple Darlington connection giving slightly more internal phase shift. Additional compensation may be added to the negative regulator by connecting a small capacitor in the 100 pF range from the negative boost terminal to the internal reference. Since the positive regulator uses the negative regulator output for a reference, this also offers some additional indirect compensation to the positive regulator.

7 AMP REGULATOR

In *Figure 14* the single external pass transistor has been replaced by a conventional Darlington using a 2N3715 and



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FIGURE 14. High Current Regulator Using a Darlington Pair for Pass Elements

a 2N3772. With this configuration the output current can reach values to 10A with very good stability. The external Darlington stage increases the minimum input-output voltage differential to 4.5V. When current limit protection resistor is used, as in *Figure 14*, the maximum output current is limited by power dissipation of the 2N3772 (150W at 25°C). During normal operation this is $(V_{IN} - V_{OUT}) I_{OUT}$ (W), but it increases to $V_{IN} I_{SC}$ (W) under short circuit conditions. The short circuit output current is then:

$$I_{SC} = \frac{P_{MAX}(T_C = 25^\circ C)}{V_{IN}}$$

$$= \frac{150W}{20V (min)} = 7.5A \text{ max.}$$

I_L could be increased to 10A or more only if $I_{SC} < I_L$. A foldback current limit circuit will accomplish this. The typical load regulation is 40 mV from no load to a full load. ($T_j = 25^\circ C$, pulsed load with 20 ms t_{ON} and 250 ms t_{OFF}).

FOLDBACK CURRENT LIMITING

In many regulator applications, the normal operation power dissipation in the pass device can easily be multiplied by a factor of ten or more when the output is shorted. This may destroy the pass device, and possibly the regulator, unless the heat sink is oversized to handle this fault condition. A foldback current limiting circuit reduces short circuit output current to a fraction of the full load output current thus

avoiding the need for larger heat sink. *Figure 15* shows a foldback current limiting circuit on both positive and negative regulators.

The foldback current limiting, a fraction of the output voltage must be used to oppose the voltage across the current limit sense resistor. Current limiting does not occur until the voltage across the sense resistor is higher than this opposing voltage by the amount shown in *Figure 11*. When the output is grounded, the opposing voltage is no longer present so current limiting occurs at a lower level. This is accomplished in *Figure 15* by using a programmable current source to give a constant voltage drop across R5 for the negative regulator, and by a simple resistor divider for the positive regulator. The reason for the difference between the two is that the negative regulator current limiting circuit is located between the output pass transistor and the unregulated input while the positive regulator current limiter is between the output pass transistor and the regulated output.

The operation of the positive foldback circuit is similar to that described in NSC application note AN-23. A voltage divider R1 and R2 from V_E to ground creates a fixed voltage drop across R1 opposite in polarity to the drop across R_{CL}^+ . When the load current increases to the point where the drop across R_{CL}^+ is equal to the drop across R1 plus the current limit sense voltage given in *Figure 11*, the positive regulator will begin to current limit. As the positive output begins to drop, the voltage across R1 will also decrease so that it now requires less load current to produce the cur-

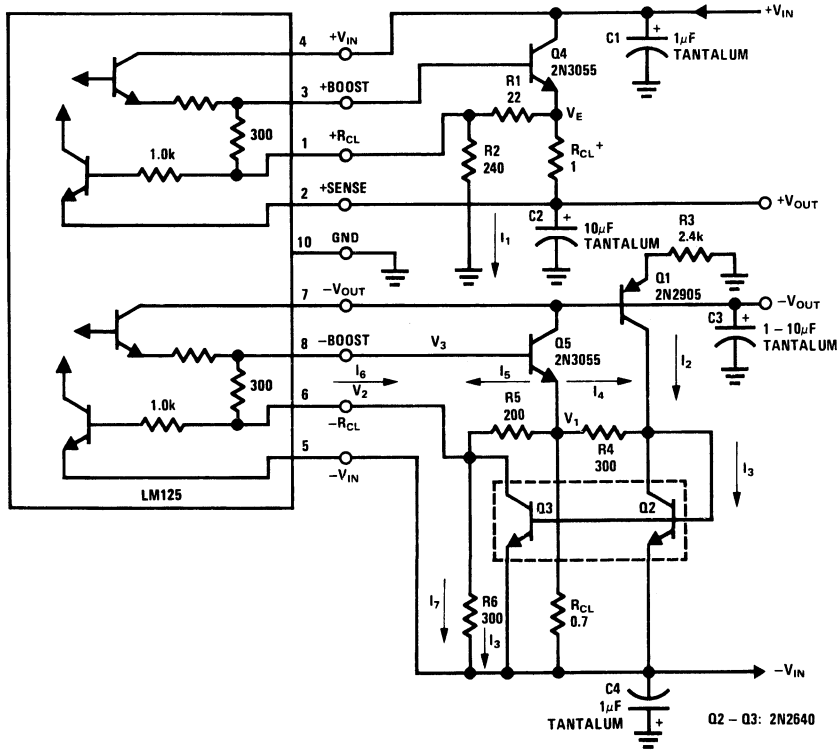


FIGURE 15. Foldback Current Limiting Circuit

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rent limit sense voltage. With the regulator output fully shorted to ground ($+V_{OUT} = 0$) the current limit will be set by the value of $+R_{CL}$ alone.

If
$$\frac{I_{FB}}{I_{SC}} \leq 5$$

then the following equations can be used for calculating the positive regulator foldback current limiting resistors.

$$R_{CL}^+ = \frac{V_{SENSE}}{I_{SC}} \quad (1)$$

where V_{SENSE} is from Figure 11.

At the maximum load current foldback point:

$$V_{R_{CL}^+} = I_{FB} R_{CL}^+ \quad (2)$$

$$V_{R1} = V_{R_{CL}^+} - V_{SENSE} \quad (3)$$

$$V_{R1} = I_{FB} R_{CL}^+ - V_{SENSE} \quad (4)$$

Then

$$R1 = \frac{V_{R1}}{I_1} \quad (5)$$

and

$$R2 = \frac{+V_{OUT} + V_{SENSE}}{I_1} \quad (6)$$

The only point of caution is to ensure that the total current (I_1) through $R2$ is much greater than the current contribution from the internal 300Ω resistor. This can be checked by:

$$\frac{I_{FB} R_{CL}^+}{300} \ll I_1 \quad (7)$$

Note: The current from the internal 300Ω resistor is $V_{3-1}/300\Omega$, but $V_{3-1} = V_{BE} + V_{R_{CL}^+} - V_{SENSE}^+$ assuming $V_{BE} \approx V_{SENSE}^+$ at the foldback point, $V_{3-1} \approx V_{R_{CL}^+} = I_{FB} R_{CL}^+$.

Design example: 2 amp regulator LM125 positive foldback current limiting (see Figure 15).

Given:

- $I_{FOLDBACK} = 2.0A$
- $I_{SHORT-CIRCUIT} = 500mA$
- V_{SENSE} (See Figure 11)
- $+V_{IN} = 25V$
- $+V_{OUT} = 15V$
- $\beta_{PASS DEVICE} = 70$
- $\theta_{JA} = 150^\circ C/W$
- $T_A = 50^\circ C$

With a beta of 70 in the pass device and a maximum output current of 2.0A the regulator must deliver:

$$\frac{2A}{\beta} = \frac{2A}{70} = 29mA$$

The LM125 power dissipation will be calculated ignoring any negative output current for this example.

$$\begin{aligned} P_{LM125} &= (V_{IN} - V_{OUT}) I_{OUT} \\ &= (25 - 15) 29mA \\ &= 290mW \end{aligned}$$

$$\begin{aligned} T_{RISE @ \theta_{JA}} &= 150^\circ C/W = 150^\circ C \times 0.29 = 44^\circ C \\ T_J &= T_A + T_{RISE} = 50^\circ C + 44^\circ C = 94^\circ C \end{aligned}$$

From Figure 11:

$$V_{SENSE} @ (T_J = 94^\circ\text{C}) = 520 \text{ mV}$$

From equation (1)

$$R_{CL}^+ = \frac{V_{SENSE}}{I_{SC}} = \frac{520 \text{ mV}}{500 \text{ mA}} \cong 1\Omega$$

From equation (2)

$$V_{R_{CL}^+} = I_{FB} R_{CL}^+ = (2A)(1\Omega) = 2V$$

From equation (3)

$$\begin{aligned} V_{R1} &= V_{R_{CL}^+} - V_{SENSE} \\ V_{R1} &= 2V - 520 \text{ mV} = 1.480V \end{aligned}$$

A value for I_1 can now be found from equation (7)

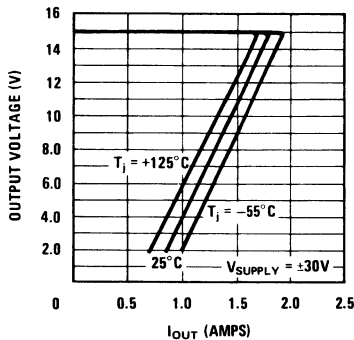
$$\frac{I_{FB} R_{CL}^+}{300} = \frac{2A \times 1\Omega}{300\Omega} = 6.6 \text{ mA}$$

So set $I_1 = 10 \times 6.6 \text{ mA} = 66 \text{ mA}$

From equations (5) and (6)

$$\begin{aligned} R1 &= \frac{V_{R1}}{I_1} = \frac{1.480V}{66 \text{ mA}} \cong 22\Omega \\ R2 &= \frac{+V_{OUT} + V_{SENSE}}{I_1} = \frac{15 + 0.520}{66 \text{ mA}} \cong 240\Omega \end{aligned}$$

The foldback limiting characteristics are shown in Figure 16 for the values calculated above at various operating temperatures.



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FIGURE 16. Positive Regulator Foldback Current Limiting Characteristics

The negative regulator foldback current limiting works essentially the same way as the positive side. Q1 forces a constant current, I_2 , determined by $-V_{OUT}$ and R3, through Q2. Transistors Q2 and Q3 are matched so a current identical to I_3 will flow through Q3. With the output short-circuited ($-V_{OUT} = 0$), Q1 will be OFF, setting $I_2 = 0$. The load current will be limited when V_1 increases sufficiently due to load current to make V_2 higher than $-V_{IN}$ by the current limit sense voltage.

The short circuit current is:

$$I_{SC} \cong \frac{V_{SENSE}}{R_{CL}^-} \quad (8)$$

For calculating the maximum full load current with the output still in regulation, current I_2

$$I_2 = \frac{V_{OUT} - V_{BEQ1}}{R3} \quad (9)$$

At the point of maximum load current, I_{FB} , where the regulator should start folding back:

$$V_1 = -V_{IN} + I_{FB} R_{CL}^- \quad (10)$$

and

$$V_2 = -V_{IN} + V_{SENSE} \quad (11)$$

The current through Q2 (and Q3) will have increased from I_2 by the amount of I_4 due to the voltage V_1 increasing above its no-load quiescent value. Since the voltage across Q2 is simply the diode drop of a base-emitter junction:

$$I_4 = \frac{[V_1 - (-V_{IN})] - V_{BE}}{R4}$$

Substituting in equation (10) gives:

$$\begin{aligned} I_4 &= \frac{I_{FB} R_{CL}^- - V_{BE}}{R4} \\ &= \frac{I_{FB} R_{CL}^- - V_{BE}}{300\Omega} \end{aligned} \quad (12)$$

The current through Q2 is now

$$I_3 = I_2 + I_4 \quad (13)$$

and the current through Q3 is:

$$I_3 = I_5 + I_6 - I_7 \quad (14)$$

The drop across R5 is found from:

$$\begin{aligned} V_1 - V_2 &= (-V_{IN} + I_{FB} R_{CL}^-) - [V_{SENSE} + (-V_{IN})]; \\ \text{simplifying,} \end{aligned}$$

$$V_1 - V_2 = I_{FB} R_{CL}^- - V_{SENSE} \quad (15)$$

Since V_{SENSE} is the base to emitter voltage drop of the internal limiter transistor, the V_{SENSE} in equation (15) very nearly equals the V_{BE} in equation (12). Therefore the drop across R5 approximately equals the drop across R4. The current through R5, I_5 , can now be determined as:

$$I_5 = \frac{I_{FB} R_{CL}^- - V_{SENSE}}{R5} \quad (16)$$

Summing the currents through Q3 is now possible assuming the base-emitter drop of the 2N3055 pass device can be given by $V_{BE} \approx V_{SENSE}$:

$$I_6 = \frac{V_3 - V_2}{300} \quad (17)$$

where $V_3 = V_1 + V_{BE} \approx V_1 + V_{SENSE}$

$$I_6 = \frac{V_1 + V_{SENSE} - V_2}{300}$$

Substituting in equation (15)

$$I_6 = \frac{I_{FB} R_{CL}^-}{300} \quad (18)$$

$$I_7 = \frac{V_2 - (-V_{IN})}{R6} = \frac{V_{SENSE}}{R6}$$

Equating equation (13) with equation (14) and inserting resistor values shown in Figure 15,

$$I_2 + I_4 = I_5 + I_6 - I_7$$

$$I_2 + \frac{I_{FB} R_{CL}^- - V_{SENSE}}{300} = \quad (19)$$

$$I_5 + \frac{I_{FB} R_{CL}^- - V_{SENSE}}{300} - \frac{V_{SENSE}}{300}$$

Canceling, we find:

$$I_2 = I_5 \quad (20)$$

This is the key to the negative foldback circuit. Current source Q1 forces current I_2 to flow through resistor R5. The voltage drop across R5 opposes the normal current limit sense voltage so that the regulator will not current limit until the drop across R_{CL}^- due to load current, equals the controlled drop across R5 plus V_{SENSE} (given in Figure 11). This can be written as:

$$I_{FB} = \frac{V_{SENSE} + I_2 R_5}{R_{CL}^-} \quad (21)$$

$$I_{FB} = \frac{V_{SENSE} + 200 I_2}{R_{CL}^-}$$

A design example is now offered:

Given:

$$I_{FOLDBACK} = 2.5A$$

$$I_{SHORT-CIRCUIT} = 750 mA$$

$$V_{SENSE} \text{ (See Figure 11)}$$

$$-V_{IN} = 25V$$

$$-V_{OUT} = -15V$$

$$\beta_{PASS DEVICE} = 90$$

$$\theta_{JA} = 150^\circ C/W$$

$$T_A = 25^\circ C$$

The same calculations are used here to figure V_{SENSE} as with the positive regulator foldback example maximum regulator output current is calculated from:

$$I_{OUT} = \frac{2.5A}{90} = 28 mA$$

$$P_{LM125} = (V_{IN} - V_O) I_{OUT}$$

$$= 10V \times 28 mA$$

$$= 280 mW$$

$$T_{RISE} = 150^\circ C/W \times 0.28W = 42^\circ C$$

$$T_J = T_A + T_{RISE} = 25^\circ C + 42^\circ C = 67^\circ C$$

From Figure 11:

$$V_{SENSE} = 500 mV$$

From equation (8):

$$R_{CL}^- = \frac{500 mV}{750 mA} = 0.68\Omega$$

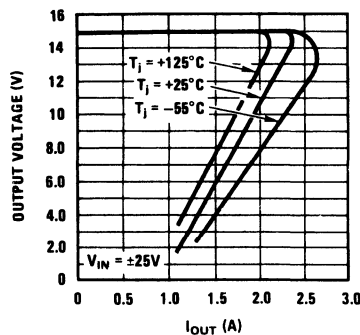
From equation (21):

$$I_2 = \frac{I_{FB} R_{CL}^- - V_{SENSE}}{200\Omega} = 6.0 mA$$

From equation (9):

$$R_3 = \frac{V_{OUT} - V_{BEQ1}}{I_2}$$

$$R_3 \cong \frac{14.3}{6.0 mA} = 2.4k$$



TL/H/7390-20

FIGURE 17. Negative Regulator Foldback Current Limiting Characteristics

Figure 16 and 17 show the measured foldback characteristics for the values derived in the design examples. The value of R5 is set low so that the magnitude of I_5 for foldback is greater than I_4 through I_6 . This reduces the foldback point sensitivity to the TC of the internal 300 Ω resistor and any mismatch in the TC of Q2, Q3 or the pass device.

R6 can be computed from equation (18):

$$R_6 = \frac{V_{SENSE}^-}{I_7} = \frac{V_{SENSE}^-}{I_5 + I_6 - I_3}$$

combining (13) and (20).

$$R_6 = \frac{V_{SENSE}^-}{I_6 - I_4}$$

$$= \frac{V_{SENSE}^-}{I_{FB} R_{CL}^- \left(\frac{1}{300} - \frac{1}{R_4} \right) + \frac{V_{BE}}{R_4}} \quad (22)$$

Setting $V_{BE} \cong V_{SENSE}$ and $R_4 = 300$ to match the internal 300 Ω (22) becomes:

$$R_6 = R_4$$

$$\text{Also setting } \frac{I_4}{I_5} = \frac{2}{3} \rightarrow R_5 = 200$$

A 10 AMP REGULATOR

Figure 18 illustrates the complete schematic of a 10A regulator with foldback current limiting. The design approach is similar to that of the 2A regulator. However, in this design, the current contribution from the internal 300 Ω resistor is greater due to the 2 V_{BE} drop across the Darlington pair. Expression (7) becomes:

$$\frac{I_{FB} R_{CL}^+ + V_{BE}}{300} < I_1; \quad (23)$$

and, for the negative regulator, expression (22) becomes:

$$R_6 = \frac{V_{SENSE}^-}{I_{FB} R_{CL}^- \left[\frac{1}{300} - \frac{1}{R_4} \right] + V_{BE} \left[\frac{1}{300} + \frac{1}{R_4} \right]} \quad (24)$$

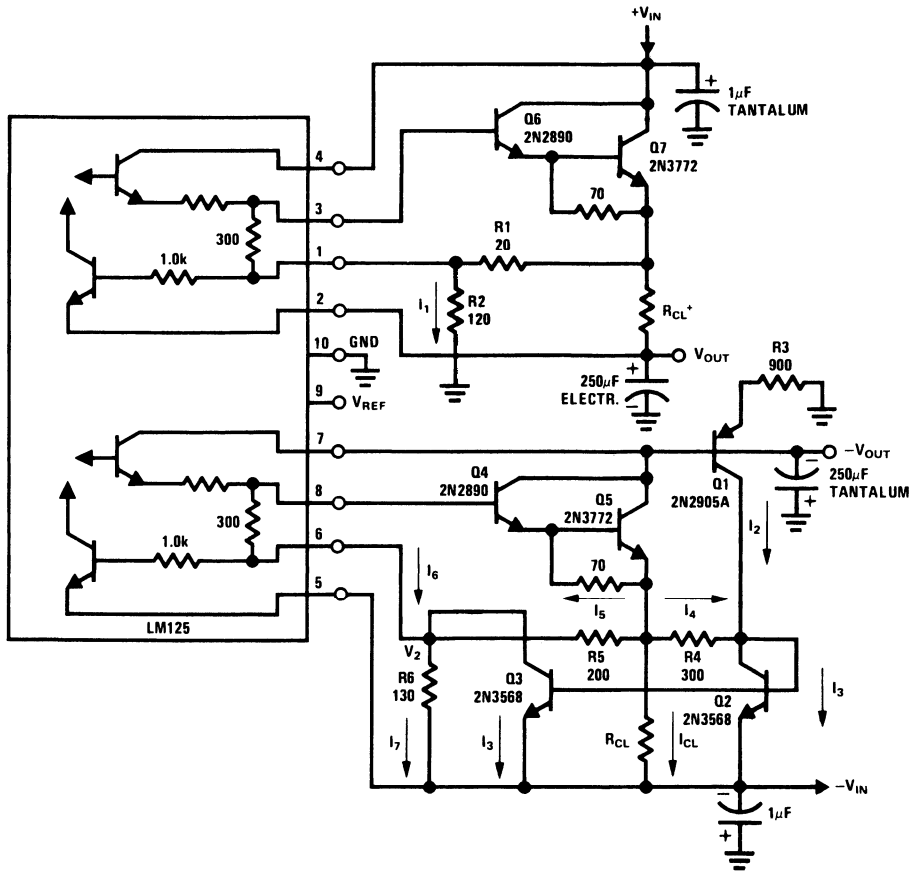


FIGURE 18. 10A Regulator with Foldback Current Limiting

TL/H/7390-22

The disagreement between the theoretical and experimental values for the negative regulator is not alarming. In fact R_{CL} was based on equation (8), which is correct if for zero V_{OUT} , I_5 is zero as well. This implies:

$$V_{SENSE} \text{ (at SC)} = \frac{V_{BEQ4} + V_{BEQ5} \text{ (at SC)}}{2}$$

which is a first order approximation.

Figure 19 illustrates the power dissipation in the external power transistor for both sides. Maximum power dissipation occurs between full load and short circuit so the heat sink for the 2N3772 must be designed accordingly, remembering that the 2N3772 must be derated according to 0.86W/°C above 25°C. This corresponds to a thermal resistance junction to case of 1.17°C/W.

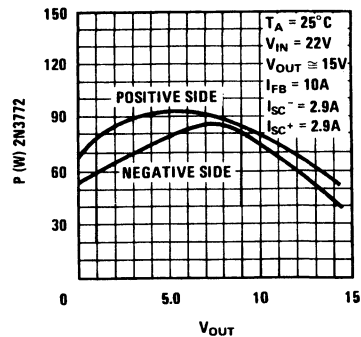


FIGURE 19. Power Dissipation in the External Pass Transistor (Q5, Q7)

TL/H/7390-21

Example

Positive Side	Theoretical Value	Experimental Results
$I_{FB} = 10A$	$I_{125} = 13 \text{ mA}$	$I_{FB} = 9.8A$
$I_{SC} = 2.5A$	$P_{LM125} = 150 \text{ mW}$	$I_{SC} = 2.9A$
$V_{IN} = 22V$	$R_{CL}^+ = 0.26\Omega$	$R_{CL}^+ = 0.26\Omega$
$V_{OUT} = 15V$	$R1 = 21\Omega$	$R1: \text{adjusted to } 20\Omega$
$\beta = \beta_1 \beta_2 = 15 \times 50 = 750 \text{ min}$	$R2 = 130\Omega$	$R2: \text{adjusted to } 120\Omega$
$T_A = 25^\circ C$	$V_{SENSE}^+ = 650 \text{ mV}$	

Negative Side	Theoretical Value	Experimental Results
$I_{FB} = 10A$	$R_{CL}^- = 0.22\Omega$	$I_{FB} = 10A$
$I_{SC} = 2.5A$	$R4 = 300\Omega$	$I_{SC} = 2.9A$
$V_{IN} = 22V$	$R5 = 200\Omega$	$R_{CL}: \text{adjusted to } 0.3\Omega$
$V_{OUT} = 15V$	$R6 = 150\Omega$	$R6: \text{adjusted to } 130\Omega$
$\beta = 800$	$R3 = 1.6 \text{ k}\Omega$	$R3: \text{adjusted } 900\Omega$
$T_A = 25^\circ$	$V_{SENSE}^- = 550 \text{ mV}$	
$\frac{I_4}{I_5} = \frac{2}{3}$		

Note: For this example, in designing each side, the power dissipation of the opposite side has not been taken into the account.

POSITIVE CURRENT DEPENDENT SIMULTANEOUS CURRENT LIMITING

The LM125, LM126 uses the negative output as a reference for the positive regulator. As a consequence, whenever the negative output current limits, the positive output follows tracks to within 200–800 mV of ground. If, however, the positive regulator should current limit the negative output will remain in full regulation. This imbalance in output voltages could be a problem in some supply applications.

As a solution to this problem, a simultaneous limiting scheme, dependent on the positive regulator output current, is presented in *Figure 20*. The output current causes an I-R drop across R1 which brings transistor Q1 into conduction. As the positive load current increases I_1 increases until the voltage drop across R2 equals the negative current limit sense voltage. The negative regulator will then current limit, and positive side will closely follow the negative output down to a level of 700–800 mV. For V_{OUT}^+ to drop the final 700–800 mV with small output current change, R_{CL}^+ should be adjusted so that the positive current limit is slightly larger than the simultaneous limiting. *Figure 21* illustrates the simultaneous current limiting of both sides.

The following design equations may be used:

$$R1 I_{CL}^+ = R3 I_1 + V_{BEQ1} \quad (25)$$

$$I_1 = \frac{V_{SENSE}^-}{R2} \quad (26)$$

Combining (25) and (26),

$$I_{CL}^+ = \frac{\frac{R3}{R2} V_{SENSE}^- + V_{BEQ1}}{R1} \quad (27)$$

with

$$R_{CL}^+ = \frac{V_{SENSE}^+}{1.1 I_{CL}^+} \quad (28)$$

The negative current limit (independent of I_{CL}^+) can be set at any desired level.

$$I_{CL}^- = \frac{V_{SENSE}^- + V_{DIODE}}{R_{CL}^-} \quad (29)$$

Transistor Q2 turns off the negative pass transistor during simultaneous current limiting.

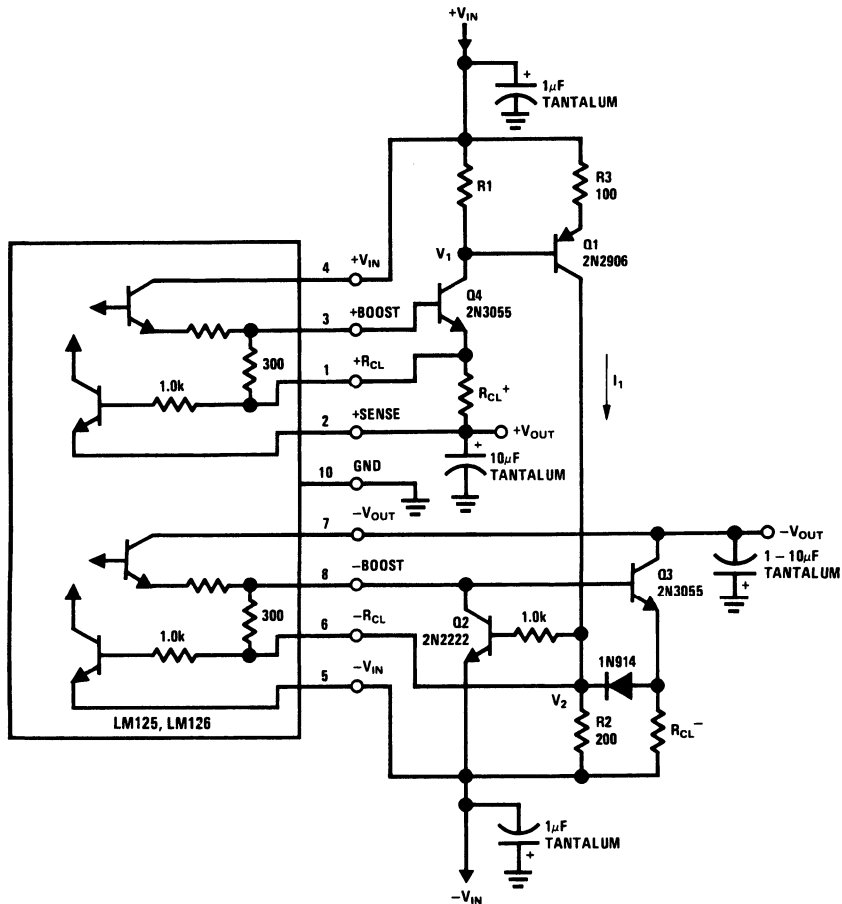
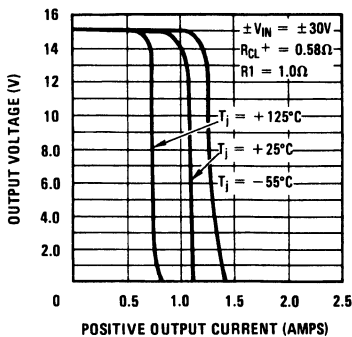


FIGURE 20. Positive Current Dependent Simultaneous Current Limiting

TL/H/7390-23



TL/H/7390-24

FIGURE 21. Positive Current Dependent Simultaneous Shutdown

ELECTRONIC SHUTDOWN

In some regulated supply applications it is desirable to shut-down the regulated outputs ($\pm V_O = 0$) without having to shut-down the unregulated inputs (which may be powering additional equipment). Various shutdown methods may be

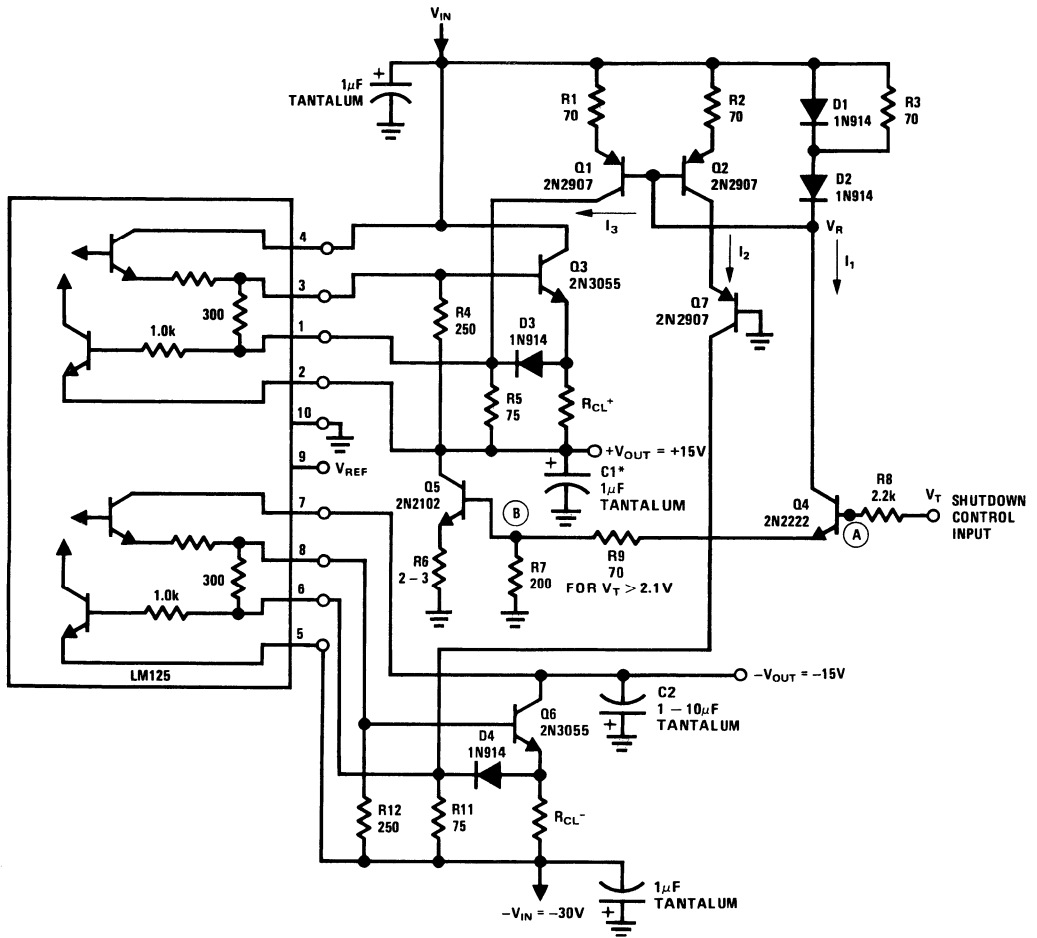
used. The simplest is to insert a relay, a saturated bipolar device, or some other type switch in series with either the regulator inputs or outputs. The switch must be able to open and close under maximum load current which, may be several amps.

As an alternate solution, the internal reference voltage of the regulator may be shorted to ground. This will force the positive and negative outputs to approximately +700 mV and +300 mV respectively. Both outputs are fully active so the full output current can still be supplied into a low impedance load. If this is unacceptable, another solution must be found.

The circuit in *Figure 22* provides complete electronic shut-down of both regulators. The shutdown control signal is TTL compatible but by adjusting R8 and R9 the regulator may be shutdown at any desired level above $2 V_{BE}$, calculated as follows:

$$V_T \cong \left[\frac{R8}{R3 \beta Q4} + \frac{R9}{R3} \right] V_{BE} + 2 V_{BE} \quad (30)$$

Positive and negative shutdown operations are similar. When a shutdown signal V_T is applied, Q4 draws current through R3 and D2 establishing a voltage V_R which starts



*For higher values of C1 increase R6 to limit the peak current through Q5 to a safe value.

TL/H/7390-25

FIGURE 22. Electronic Shutdown for the Boosted Regulator

the current sources Q1 and Q2. Assuming that Q1 and Q2 are matched, and making $R1 = R2 = R3$, the currents I_1 , I_2 , I_3 are equal and both sides of the regulator shutdown simultaneously.

The current I_3 creates a drop across R5, which equals or exceeds the limit sense voltage of the positive regulator, causing it to shutdown. Since I_3 has no path to ground except through the load, a fixed load is provided by Q5, which is turned on by the variable current source Q4. C1 also discharges through Q5 and current limiting resistor R6. Resistor R4 prevents Q3 turn on during shutdown, which could otherwise occur due to the drop across R5 plus the internal 300Ω resistor. Diode D3 prevents I_3 from being shunted through R_{CL} .

C2 discharges through the load. Q7 shares the total supply voltage with Q2, thus limiting power dissipation of Q2. Another power dissipation problem may occur when the design is done for $V_T = 2.0V$ for example, and V_T is increased above the preset threshold value. I_1 is increased and Q4 has to dissipate $(V_{IN} - 3V_{BE} - V_T) I_1$ (W). The simplest solution is to increase R8. If this is insufficient, a set of diodes may be added between nodes A and B to clamp, I_1 to a reasonable value. This is illustrated in Figure 23:

$$I_1 = \frac{V_{R9}}{R9} \approx \frac{V_T - V_{BE} - [V_T - 2V_{BE}]}{R9} = \frac{V_{BE}}{R9}$$

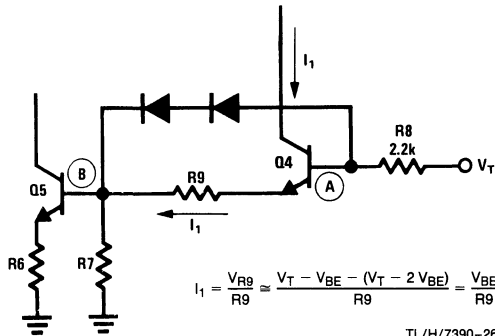
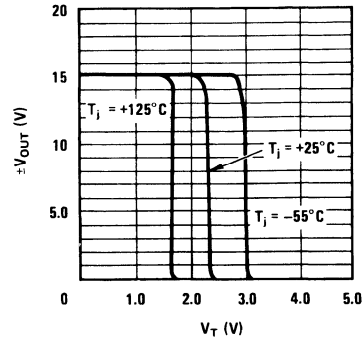


FIGURE 23

So I_1 is made independent of V_T and by setting a minimum value of 10 mA ($R9 = 70\Omega$). The regulator will shutdown at any desired level above $3V_{BE}$, without overheating transis-

tor Q4. Also using Figure 23 the diode D1 in Figure 22 may be omitted. The shutdown characteristics of Figure 22 are shown in Figure 24.



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FIGURE 24. Electronic Shutdown Characteristics

The normal current limiting current is set by equation (31)

$$I_{CL} = \frac{V_{SENSE} + V_{DIODE}}{R_{CL}} \quad (31)$$

The same approach is used with the unboosted regulator shown in Figure 25. In this case the voltage sense resistor is the internal 300Ω one. Since output capacitors are no longer required Q3 is just used as a current sink and its emitter load has been removed.

POWER DISSIPATION

The power dissipation of the LM125 is:

$$P_d = (V_{IN}^+ - V_{OUT}^+) I_{OUT}^+ + (V_{IN}^- - V_{OUT}^-) I_{OUT}^- + V_{IN}^+ I_{S}^+ + V_{IN}^- I_{S}^-$$

where I_S is the standby current.

Ex: $\pm 1A$ regulator using 2N3055 pass transistors. Assuming a $\beta = 100$, and $\pm 25V$ supply,

$$P_d = 400 \text{ mW.}$$

The temperature rise for the TO-5 package will be:

$$T_{RISE} = 0.4 \times 150^\circ\text{C/W} = 60^\circ\text{C}$$

Therefore the maximum ambient temperature is $T_{AMAX} = T_{JMAX} - T_{RISE} = 90^\circ\text{C}$. If the device is to operate at T_A above 90°C then the TO-5 package must have a heat sink. T_{RISE} in this case will be:

$$T_{RISE} = P_d (\theta_{J-C} + \theta_{C-S} + \theta_{S-A}).$$

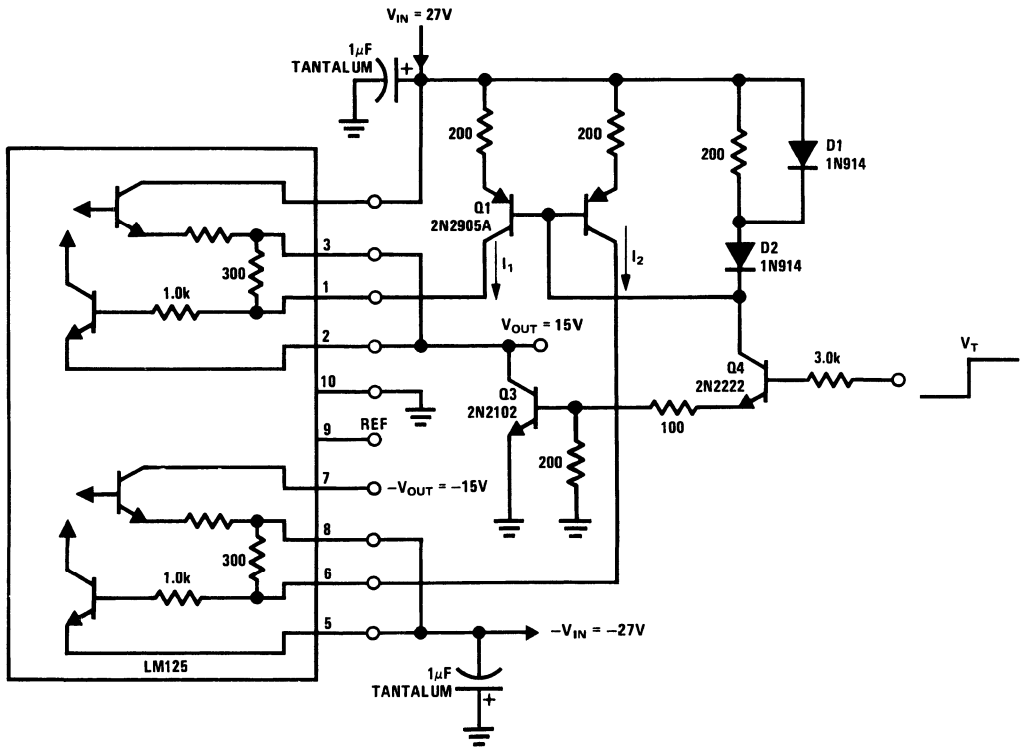


FIGURE 25. Electronic Shutdown for the Basic Regulator

TL/H/7390-28

Comparing the High Speed Comparators

National Semiconductor
Application Note 87
Interface
Development Group



INTRODUCTION

Several integrated circuit voltage comparators exist which were designed with high speed and complementary TTL outputs as the main objectives. The more common applications for these devices are high speed analog to digital (A to D) converters, tape and disk-file read channels, fast zero-crossing detectors, and high speed differential line receivers. This note compares the National Semiconductor devices to similar devices from other manufacturers.

The product philosophy at National was to create pin-for-pin replacement circuits that could be considered as second-sources to the other comparators, while simultaneously containing the improvements necessary to make a more op-

timum device for the intended usage. Optimized parameters include speed, input accuracy and impedance, supply voltage range, fanout, and reliability. The LM160/LM260/LM360 are replacement devices for the μ A760, while the LM161/LM261/LM361 replace the SE/NE529. Tables I and II compare the critical parameters of the National commercial range devices to their respective counterparts.

SPEED

Throughout the universe the subject of speed must be approached with caution; the same holds true here. Speed (propagation delay time) is a function of the measurement

TABLE I. LM360/ μ A760C Comparison $0^\circ\text{C} \leq T_A \leq +70^\circ\text{C}$, $V^+ = +5.0\text{V}$, $V^- = -5.0\text{V}$

Parameter	LM360	μ A760C	Units
Input Offset Voltage	5.0	6.0	mV max
Input Offset Current	3.0	7.5	μ A max
Input Bias Current	20	60	μ A max
Input Capacitance	4.0	8.0	pF typ
Input Impedance	17	5.0	k Ω typ @ 1 MHz 25°C
Differential Voltage Range	± 5.0	± 5.0	V typ
Common Mode Voltage Range	± 4.0	± 4.0	V typ
Gain	3.0	3.0	V/mV typ 25°
Fanout	4.0	2.0	74 Series TTL Loads
Propagation Delays:			
(1) 30 mVp-p 10 MHz Sinewave in	25	30	ns max 25°
(2) 2.0 Vp-p 10 MHz Sinewave in	20	25	ns max 25°
(3) 100 mV Step + 5.0 mV Overdrive	14	22	ns typ 25°

TABLE II. LM261/NE529 Comparison $0^\circ\text{C} \leq T_A \leq +70^\circ\text{C}$, $V^+ = +10\text{V}$, $V^- = -10\text{V}$, $V_{CC} = +5.0\text{V}$

Parameter	LM261	NE529	Units
Input Offset Voltage	3.0	10	mV max
Input Offset Current	3.0	15	μ A max
Input Bias Current	20	50	μ A max
Input Impedance	17	5.0	k Ω typ @ 1 MHz 25°C
Differential Voltage Range	± 5.0	± 5.0	V typ
Common Mode Voltage Range	± 6.0	± 6.0	V typ
Gain	3.0	4.0	V/mV typ 25°
Fanout	4.0	6.0	74 Series TTL Loads
Propagation Delay - 50 mV Overdrive	20	22	ns max 25°

technique. The earlier "standard" of using a 100 mV input step with 5.0 mV overdrive has given way to seemingly endless variations. To be meaningful, speed comparisons must be made with identical conditions. It is for this reason that the speed conditions specified for the National parts are the same as those of the parts replaced.

Probably the most impressive speed characteristic of the six National parts is the fact that propagation delay is essentially independent of input overdrive (*Figure 1*); a highly desirable

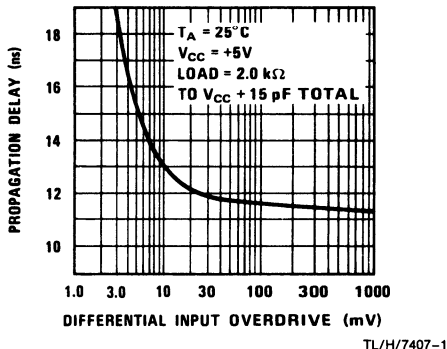


FIGURE 1. Delay vs Overdrive

characteristic in A to D applications. Their delay typically varies only 3 ns for overdrive variations of 5.0 mV to 500 mV, whereas the other parts have a corresponding delay variation of two to one. As can be seen in Tables I and II, the National parts have an improved maximum delay specification. Further, the 20 ns maximum delay is meaningful since it is specified with a representative load: a 2.0 k Ω resistor to +5.0V and 15 pF total load capacitance. *Figure 2* shows typical delay variation with temperature.

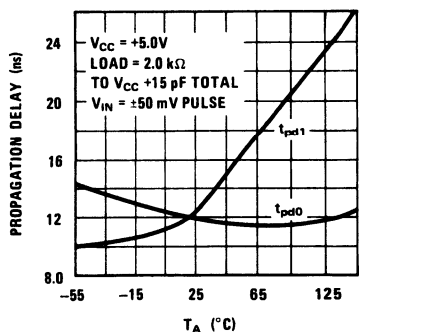


FIGURE 2. Delay vs Temperature

INPUT PARAMETERS

The A to D, level detector, and line receiver applications of these devices require good input accuracy and impedance. In all these cases the differential input voltage is relatively

large, resulting in a complete switch of input bias current as the input signal traverses the reference voltage level. This effect can give rise to reduced gain and threshold inaccuracy, dependent on input source impedances and comparator input bias currents. Tables I and II show that the National parts have a substantially lower maximum bias current to ease this problem. This was done without resorting to Darlington input stages whose price is higher offset voltages and longer delay times. The lower bias currents also raise input resistance in the threshold region. Lower input capacitance and higher input resistance result in higher input impedance at high frequencies.

Even with low source impedances, input accuracy is still dependent on offset voltage. Since none of the devices under discussion has internal offset null capability, ultimate accuracy was improved by designing and specifying lower maximum offset voltage. Refer to *Figure 3* for typical offset voltage drift with temperature.

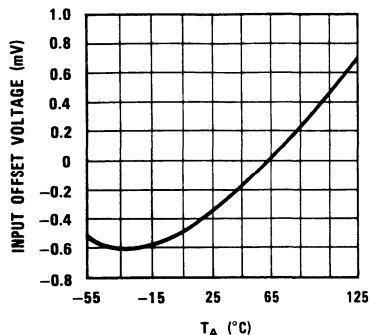


FIGURE 3. Offset Temperature Coefficient

OTHER PERFORMANCE AREAS

In the case of the LM160/LM260/LM360, fanout was doubled over the previous device. For the LM161/LM261/LM361, operating supply voltage range was extended to

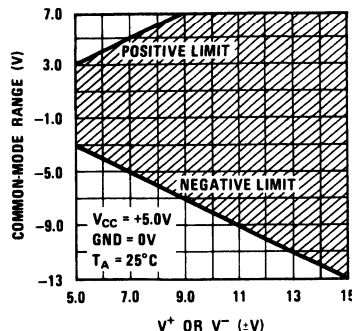


FIGURE 4. LM161 Common Mode Range

$\pm 15V$ op amp supplies which are often readily available where such a comparator is used. *Figure 4* reveals the common mode range of the latter device.

The performance improvements previously mentioned were a result of circuit design (Figures 5 and 6) and device processing. Schottky clamping, which can give rise to reliability problems, was not used. Gold doping, which results in processing dependent speeds and low transistor beta, was not used. Instead a non-gold-doped process with high breakdown voltage, high beta, and high f_T (≈ 1.5 GHz) was se-

lected which produced remarkably consistent performance independent of normal process variation. The higher breakdown voltage allows the LM161/LM261/LM361 to operate on $\pm 15V$ supplies and results in lower transistor capacitance; higher beta provides lower input bias currents; and higher f_T helps reduce propagation time.

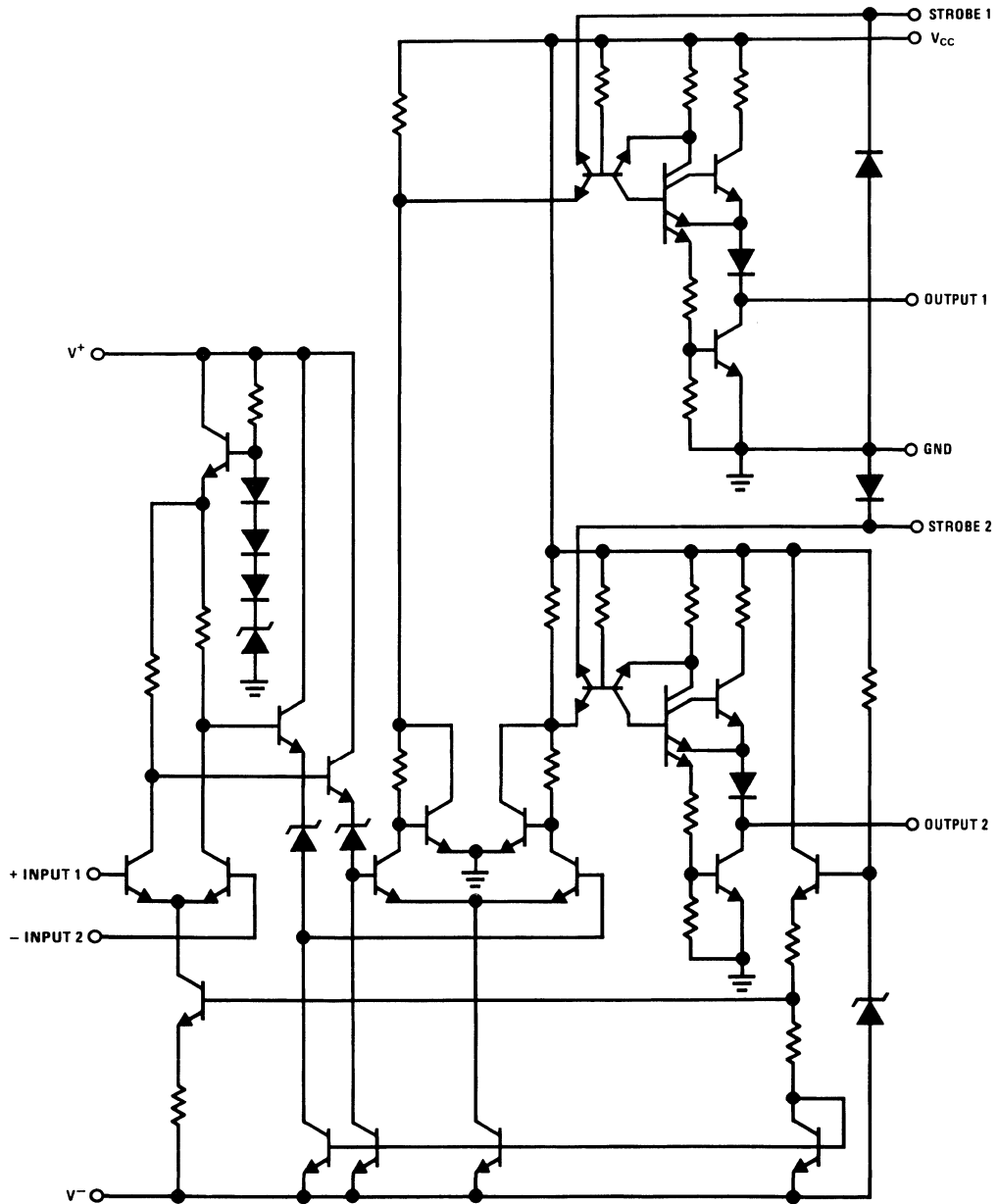


FIGURE 5. LM161 Schematic Diagram

TL/H/7407-5

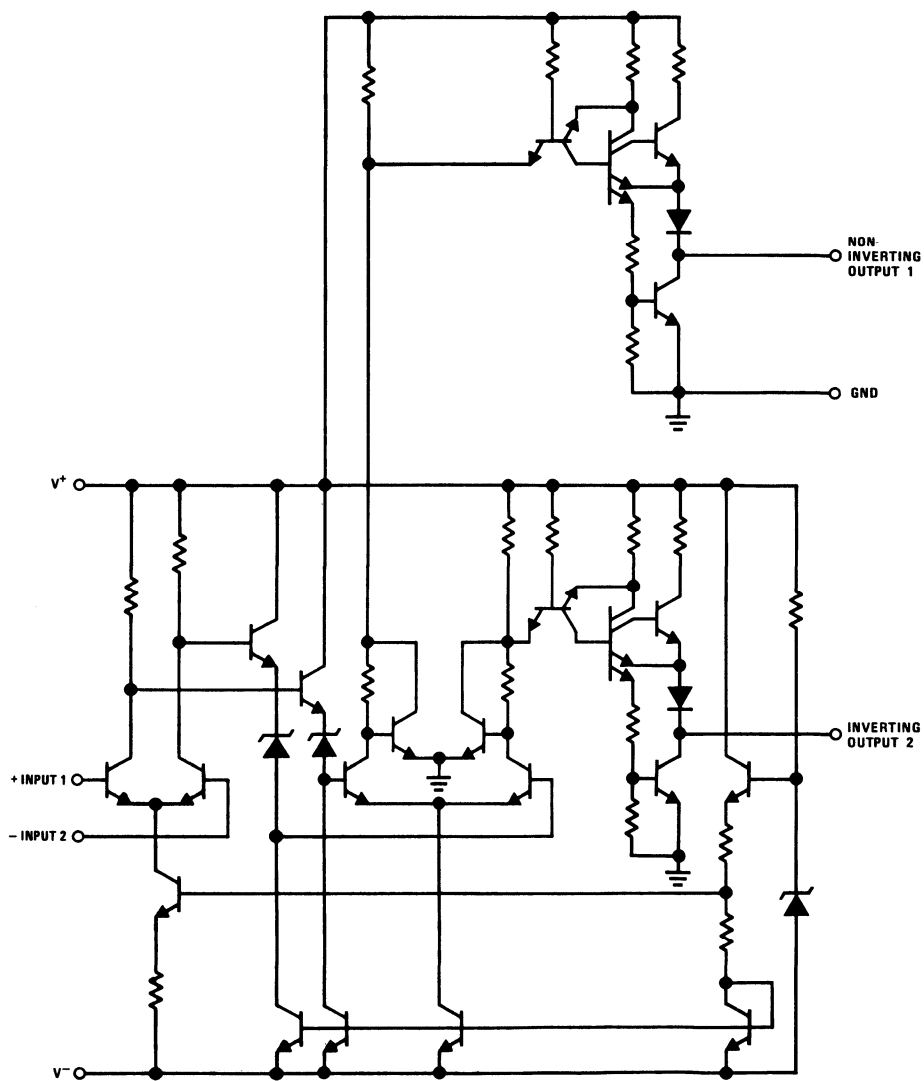


FIGURE 6. LM160 Schematic Diagram

TL/H/7407-6

APPLICATIONS

Typical applications have been mentioned previously. The LM160 and LM161 may be combined as in *Figure 7* to create a fast, accurate peak detector for use in tape and disk-file read channels. A 3-bit A to D converter with 21 ns typical conversion time is shown in *Figure 8*. Although primarily in-

tended for interfacing to TTL logic, direct connection may be made to ECL logic from the LM161 by the technique shown in *Figure 9*. When used this way the common mode range is shifted from that of the TTL configuration. Finally level detectors or line receivers may be implemented with hysteresis in the transfer characteristic as seen in *Figure 10*.

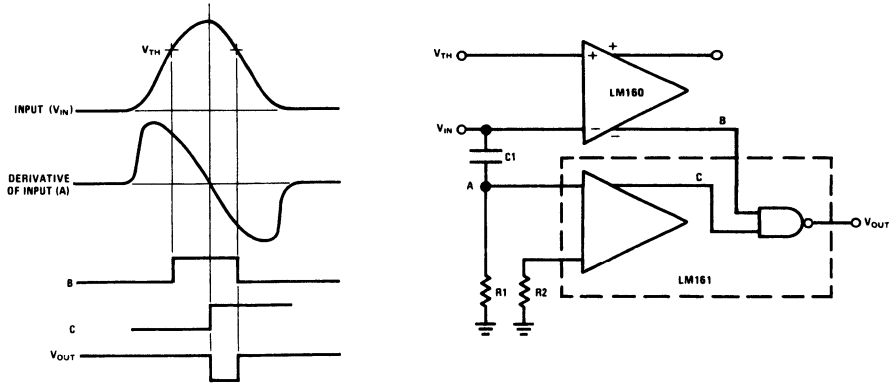


FIGURE 7. Peak Detector

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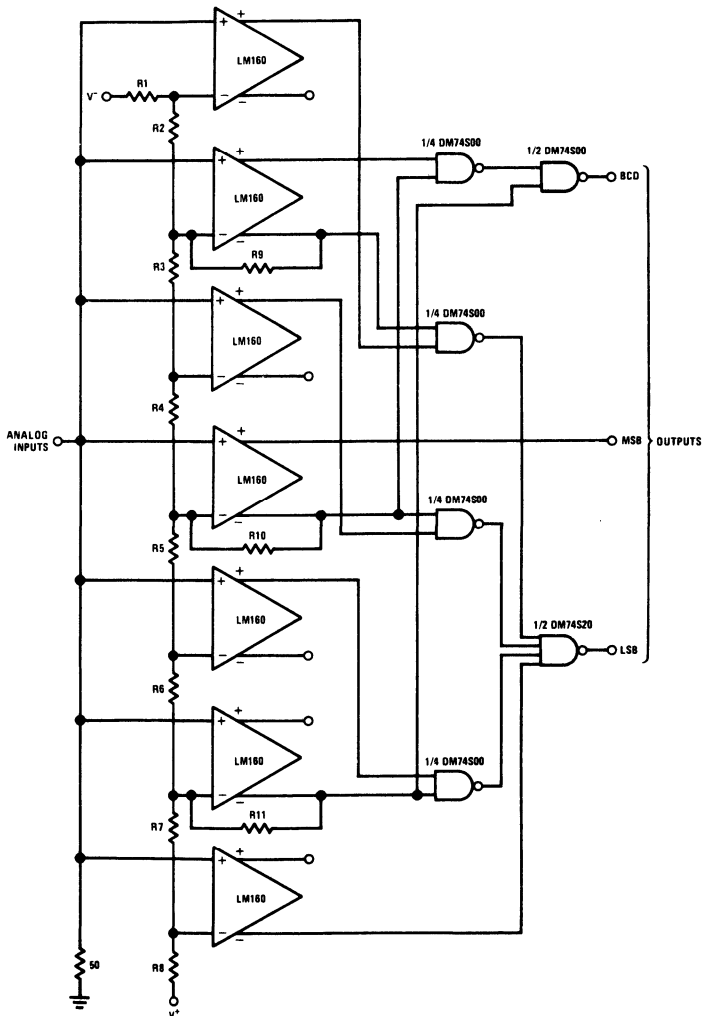


FIGURE 8. High Speed 3-bit A to D Converter

TL/H/7407-8

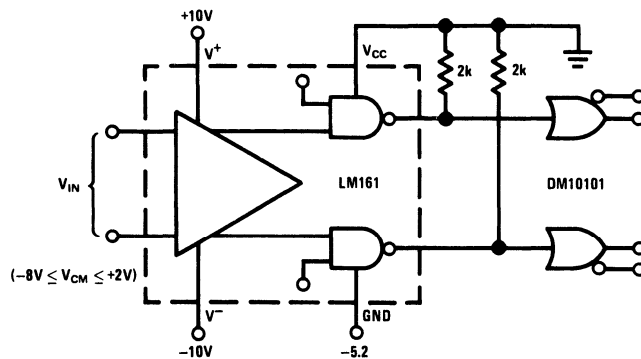
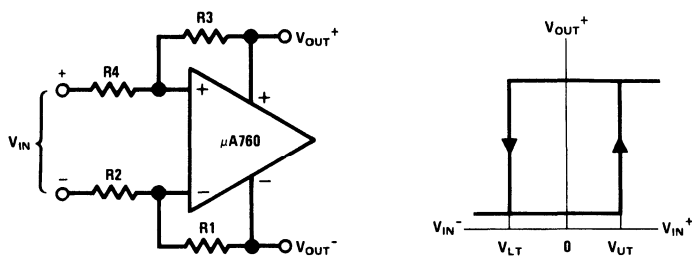


FIGURE 9. Direct Interfacing to ECL

TL/H/7407-9



TL/H/7407-10

$$V_{UT} = V_{OH} \left(\frac{R_2}{R_1} \right) - V_{OL} \left(\frac{R_4}{R_3} \right)$$

$$V_{LT} = V_{OL} \left(\frac{R_2}{R_1} \right) - V_{OH} \left(\frac{R_4}{R_3} \right)$$

FIGURE 10. Level Detector with Hysteresis

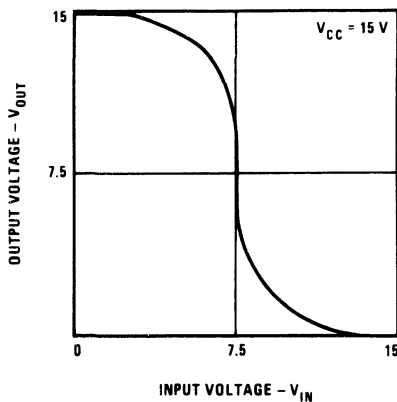
CMOS Linear Applications

National Semiconductor
Application Note 88



PNP and NPN bipolar transistors have been used for many years in "complementary" type of amplifier circuits. Now, with the arrival of CMOS technology, complementary P-channel/N-channel MOS transistors are available in monolithic form. The MM74C04 incorporates a P-channel MOS transistor and an N-channel MOS transistor connected in complementary fashion to function as an inverter.

Due to the symmetry of the P- and N-channel transistors, negative feedback around the complementary pair will cause the pair to self bias itself to approximately 1/2 of the supply voltage. *Figure 1* shows an idealized voltage transfer characteristic curve of the CMOS inverter connected with negative feedback. Under these conditions the inverter is biased for operation about the midpoint in the linear segment of the steep transition of the voltage transfer characteristics as shown in *Figure 1*.

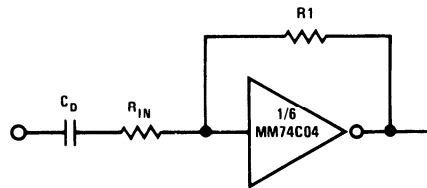


TL/F/6020-1

FIGURE 1. Idealized Voltage Transfer Characteristics of an MM74C04 Inverter

Under AC Conditions, a positive going input will cause the output to swing negative and a negative going input will have an inverse effect. *Figure 2* shows 1/6 of a MM74C04 inverter package connected as an AC amplifier.

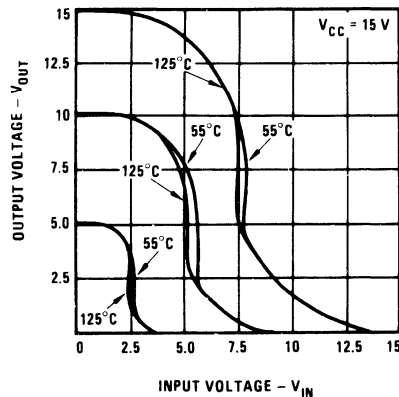
The power supply current is constant during dynamic operation since the inverter is biased for Class A operation. When the input signal swings near the supply, the output signal will become distorted because the P-N channel devices are driven into the non-linear regions of their transfer character-



TL/F/6020-2

FIGURE 2. A 74CMOS Inverter Biased for Linear Mode Operation

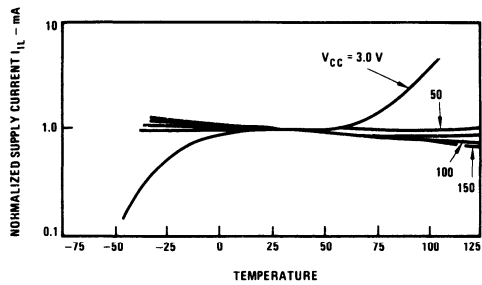
istics. If the input signal approaches the supply voltages, the P- or N-channel transistors become saturated and supply current is reduced to essentially zero and the device behaves like the classical digital inverter.



TL/F/6020-3

FIGURE 3. Voltage Transfer Characteristics for an Inverter Connected as a Linear Amplifier

Figure 3 shows typical voltage characteristics of each inverter at several values of the V_{CC} . The shape of these transfer curves are relatively constant with temperature. Temperature affects for the self-biased inverter with supply voltage is shown in *Figure 4*. When the amplifier is operating at 3 volts, the supply current changes drastically as a function of supply voltage because the MOS transistors are operating in the proximity of their gate-source threshold voltages.

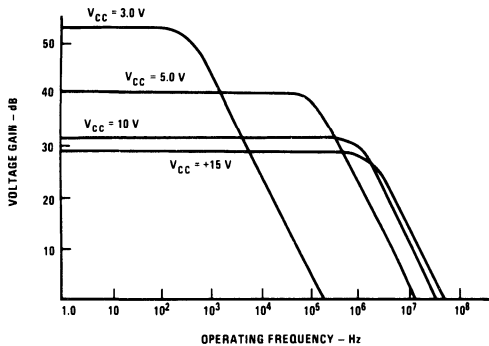


TL/F/6020-4

FIGURE 4. Normalized Amplifier Supply Current Versus Ambient Temperature Characteristics

Figure 5 shows typical curves of voltage gain as a function of operating frequency for various supply voltages.

Output voltages can swing within millivolts of the supplies with either a single or a dual supply.



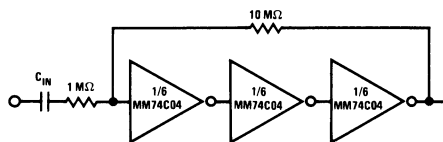
TL/F/6020-5

FIGURE 5. Typical Voltage Gain Versus Frequency Characteristics for Amplifier Shown in Figure 2

APPLICATIONS

Cascading Amplifiers for Higher Gain

By cascading the basic amplifier block shown in Figure 2 a high gain amplifier can be achieved. The gain will be multiplied by the number of stages used. If more than one inverter is used inside the feedback loop (as in Figure 6) a higher open loop gain is achieved which results in more accurate closed loop gains.

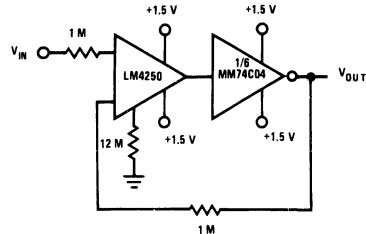


TL/F/6020-6

FIGURE 6. Three CMOS Inverters Used as an X10 AC Amplifier

Post Amplifier for Op Amps

A standard operational amplifier used with a CMOS inverter for a Post Amplifier has several advantages. The operational amplifier essentially sees no load condition since the input impedance to the inverter is very high. Secondly, the CMOS inverters will swing to within millivolts of either supply. This gives the designer the advantage of operating the operational amplifier under no load conditions yet having the full supply swing capability on the output. Shown in Figure 7 is the LM4250 micropower Op Amp used with a 74C04 inverter for increased output capability while maintaining the low power advantage of both devices.

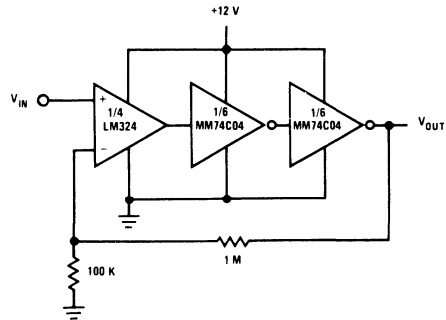


TL/F/6020-7

 $P_D = 500 \text{ nW}$

FIGURE 7. MM74C04 Inverter Used as a Post Amplifier for a Battery Operated Op Amp

The MM74C04 can also be used with single supply amplifier such as the LM324. With the circuit shown in Figure 8, the open loop gain is approximately 160 dB. The LM324 has 4 amplifiers in a package and the MM74C04 has 6 amplifiers per package.



TL/F/6020-8

FIGURE 8. Single Supply Amplifier Using a CMOS Cascade Post Amplifier with the LM324

CMOS inverters can be paralleled for increased power to drive higher current loads. Loads of 5.0 mA per inverter can be expected under AC conditions.

Other 74C devices can be used to provide greater complementary current outputs. The MM74C00 NAND Gate will provide approximately 10 mA from the V_{CC} supply while the

MM74C02 will supply approximately 10 mA from the negative supply. Shown in *Figure 9* is an operational amplifier using a CMOS power post amplifier to provide greater than 40 mA complementary currents.

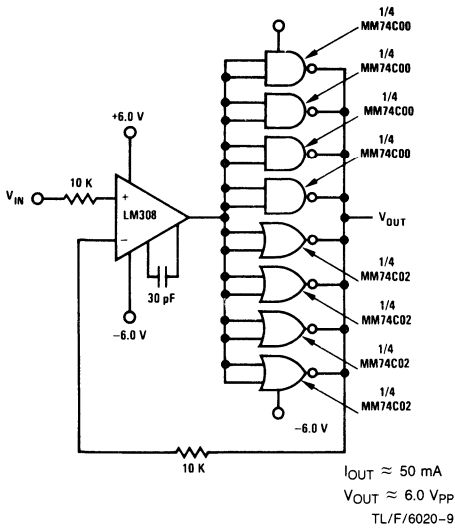


FIGURE 9. MM74C00 and MM74C02 Used as a Post Amplifier to Provide Increased Current Drive

Other Applications

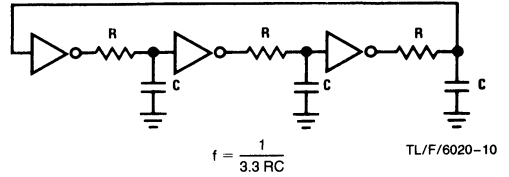
Shown in *Figure 10* is a variety of applications utilizing CMOS devices. Shown is a linear phase shift oscillator and an integrator which use the CMOS devices in the linear mode as well as a few circuit ideas for clocks and one shots.

Conclusion

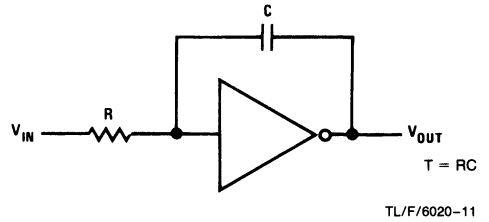
Careful study of CMOS characteristics show that CMOS devices used in a system design can be used for linear building blocks as well as digital blocks.

Utilization of these new devices will decrease package count and reduce supply requirements. The circuit designer now can do both digital and linear designs with the same type of device.

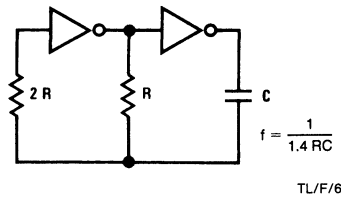
Phase Shift Oscillator Using MM74C04



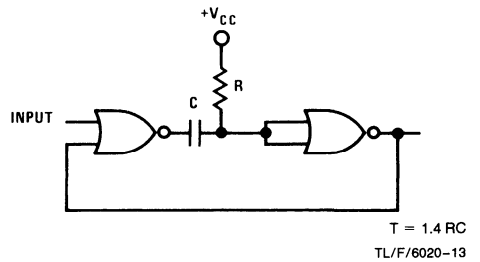
Integrator Using Any Inverting CMOS Gate



Square Wave Oscillator



One Shot



Staircase Generator

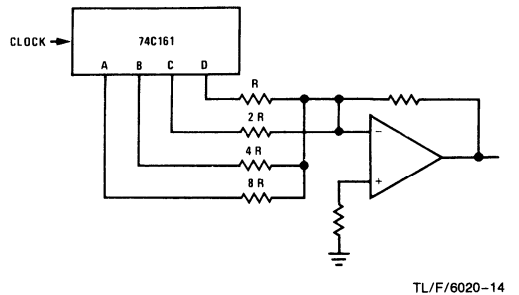


FIGURE 10. Variety of Circuit Ideas Using CMOS Devices

Versatile Timer Operates from Microseconds to Hours

National Semiconductor
Application Note 97



AN-97

INTRODUCTION

Timing functions, until recently, have been somewhat neglected by integrated circuit manufacturers. The primary reason was the extremely wide range of input and output signals currently incorporated in discrete designs. In addition, power supply voltages varied over a ten to one range and timing periods were as short as microseconds and as long as hours.

The LM122 timer has been designed to operate over a very wide range of input/output signal levels, supply voltages, and timing periods. It will replace most discrete designs with improved performance and reliability. This new timer overcomes many of the problems incurred in discrete or early IC designs.

First, it locks out trigger signals during the timing period to guarantee a precise output regardless of trigger level—while maintaining the ability to be retriggered almost immediately following the end of the timing pulse. (Duty cycles up to 99.9% can be achieved.) Secondly, the timing period is free from jitter caused by supply fluctuations because the timing components are driven from an internal regulated source. Supply voltage for the timer can vary from 4.5V to 40V even during the timing period! An additional feature is the $\pm 40V$ excursion allowed on the trigger input and the 40V/50 mA drive capability of the output transistor. These two specifications allow the LM122 to interface directly to present designs without level shift or power boosting problems. Finally, the LM122 will generate stable timing periods from several microseconds to hours—a useful range of eight decades. Worst case guarantees on comparator bias current and threshold level allow the user to easily select timing components for maximum accuracy.

CIRCUIT DESCRIPTION

The LM122 circuitry can be divided into five separate sections: output stage, bias network, voltage regulator, comparator, and logic. These sections are grouped on the schematic in *Figure 1* to simplify understanding of the timer.

The floating transistor output stage of the LM122 consists of Q32 through Q36. Q36 is the actual output transistor and is driven by emitter follower, Q33. Q34 and Q35 are antisaturation camps to reduce stored charge in Q36 and to limit current through Q33. Q32 acts as a current limiter with the limit set at about 120 mA.

The regulator built into the LM122 is a $V_{BE}/\Delta V_{BE}$ type with a typical output voltage of 3.15V at up to 5.0 mA load current. Q18 and Q19 generate a 100 μA current through Q19 which has a positive temperature coefficient of 0.33%/°C. This generates 1.2V and +4 mV/°C TC across R21. When added to the base emitter diode voltages of Q20 and Q21, a 2.4V, zero TC reference is established at the base of Q21. R18 and R19 form a divider to raise the regulated voltage to 3.15V. (This particular voltage was chosen because it can be operated off a single 5.0V supply and because one RC time constant is exactly 2.0V out of 3.15V.) Q23 buffers Q21 from supply fluctuations and sets up the currents for the bias section of the timer. Q20 is a single stage of voltage

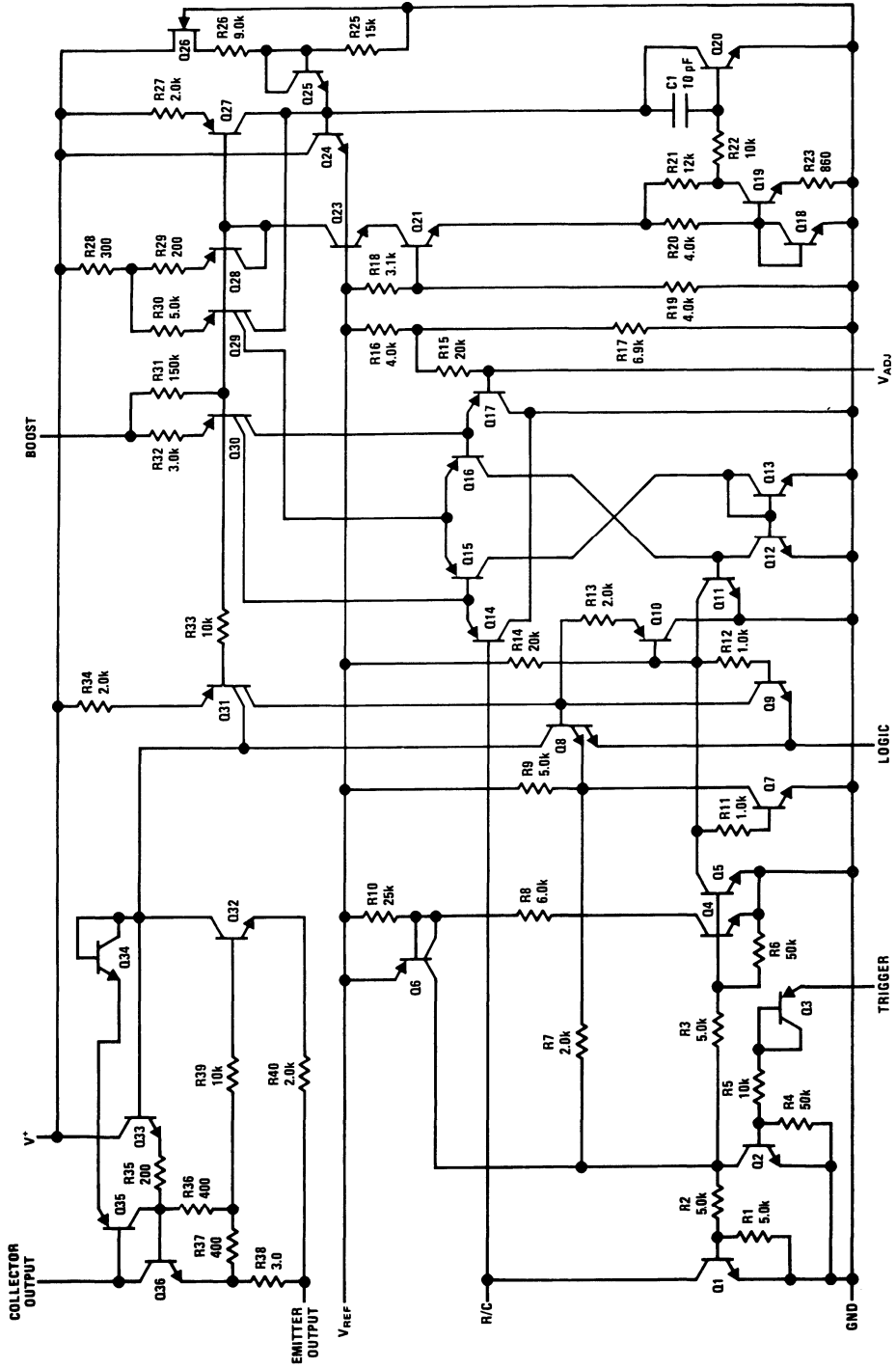
gain for the regulator. It is buffered by the series pass transistor, Q24. Q25, Q26, R25, and R26 are included for starting purposes and do not affect operation once current is flowing in the regulator section.

The function of the comparator is to cause an output change of state when the timing capacitor has charged to one RC time constant. Q11 through Q17 perform this function. Q14, Q15, Q16, and Q17 are a Darlington differential stage driving an active load formed by Q12 and Q13. Q11 is a second stage operating as a common emitter amplifier with R14 as its load resistor. For long timing intervals, the Darlington is run with no bleed current from Q30. Operating current for Q15 and Q16 is about 5 μA per side. The specially processed lateral PNP's have h_{FE} 's of about 200, so operating current for Q14 and Q17 is typically 25 nA. At these current levels, the substrate PNP's have h_{FE} 's of 80, giving comparator input currents of 300 pA! One side of the comparator is tied to a divider (R16 and R17) which is set at 63.2% of the reference voltage — one RC time constant. The other side is connected to the external timing resistor and capacitor.

The logic section of the LM122 performs four functions: first, it provides a latching action to make the circuitry immune to retriggering during the timing interval; second, it simulates the action of an exclusive OR gate to generate a logic reverse function; additionally, it translates the low level output from the comparator to the high level swing needed to drive the floating transistor output; and finally, it drives the discharge transistor to reset the timing capacitor. Q2 and Q3 makeup the TTL compatible trigger input to the logic section. Q3 is a lateral PNP with 60V reverse emitter-base breakdown voltage, allowing negative inputs are high as $-40V$ without harm to the chip. R5 is an epitaxial resistor which pinches off at 30V and has a breakdown of 80V. This allows positive input voltages of up to 40V on the trigger terminal even when operating the timer from a supply voltage of only 5.0V. Typical current drawn by the trigger terminal is 40 μA at 2.0V and 600 μA at 40V. Q4 and Q6 form a latch which self-limits at about 400 μA and can be turned off by Q2. Q5 and Q7 interface the latch to the comparator so that the comparator can fire the latch at the end of the timing period. Q8, Q9, and Q10 perform the level shifting required to drive the output transistor and double as an exclusive OR gate, with the emitters of Q8 and Q9 as one input and the collectors of Q5 and Q11 as the second input. Grounding the Q8 and Q9 emitters reverses the effect of a signal appearing at the collector of Q11.

Biasing for the various circuits in the timer is generated by a string of PNP current sources consisting of Q27 through Q31. Current levels are established by the constant current source, Q23, driving diode connected Q28. The current from Q23 is 400 μA , setting the drop across the emitter resistor, R28 plus R29, at 200 mV. Q29 delivers 10 μA to the comparator and Q31 supplies a total of 100 μA to the output transistor and logic circuitry. Part of Q29's collector is returned to Q27 to avoid having to use a large value resistor for R30. Q30 is completely off when using the timer for long timing periods. Shorting the boost terminal of V^+ adds

*See AN-42, "On Card Regulator for Logic Circuits"



TU/H/7408-1

FIGURE 1. Schematic Diagram

about 5 μA bleed current at the emitters of Q14 and Q17. This extra current is needed to slew the emitters of the comparator for timing periods less than 1 ms.

DESCRIPTION OF PIN FUNCTIONS

One of the main features of the LM122 is its great versatility. Since this device is unique, a description of the functions and limitations of each pin is in order. This will make it much easier to follow the discussion of the various applications presented in this note.

V^+ is the positive supply terminal of the LM122. When using a single supply, this terminal may be driven by any voltage between 4.5V and 40V. The effect of supply variations on timing period is less than 0.005%/V, so supplies with high ripple content may be used without causing pulse width changes. Supply bypassing on V^+ is not generally needed but may be necessary when driving highly reactive loads. Quiescent current drawn from the V^+ terminal is typically 2.5 mA, independent of the supply voltage. Of course, additional current will be drawn if the reference is externally loaded.

The V_{REF} pin is the output of a 3.15V series regulator referenced to the ground pin. Up to 5.0 mA can be drawn from this pin for driving external networks. In most applications the timing resistor is tied to V_{REF} , but it need not be in situations where a more linear charging current is required. The regulated voltage is very useful in applications where the LM122 is not used as a timer; such as switching regulators, variable reference comparators, and temperature controllers. Typical temperature drift of the reference is less than 0.01%/°C.

The trigger terminal is used to start timing. Threshold is typically 1.6V at +25°C and has a temperature dependence of $-5.0\text{ mV}/^\circ\text{C}$. Current drawn from the trigger source is typically 20 μA at threshold, rising to 600 μA at 30V, then leveling off due to FET action of the series resistor, R5. For negative input trigger voltages, the only current drawn is leakage in the nA region.

If the trigger terminal is held high as the timing period ends, the output pulse will appear normally, but the timing capacitor will not be discharged. This is a necessary circuit action to prevent repetitive cycles when the trigger is held high. After the timing period, the capacitor is discharged when the trigger decreases below the threshold, without affecting the output.

The R/C pin is tied to the uncommitted side of the comparator and to the collector of the capacitor discharge transistor. Timing ends when the voltage on this pin reaches 2.0V (1 RC time constant referenced to the 3.15V regulator). The internal discharge transistor turns on only if the trigger voltage has dropped below threshold. In comparator or regulator applications of the timer, the trigger is held permanently high and the R/C pin acts just like the input to an ordinary comparator. The maximum voltages which can be applied to this pin are +5.5V and -0.7V . Input current to the R/C pin is typically 300 pA when the voltage is negative with respect to the V_{ADJ} terminal. For higher voltages, the current drops to leakage levels. In the boosted mode, input current is 30 nA. Gain of the comparator is very high, 200,000 or more depending on the state of the logic reverse pin and the connection of the output transistor.

The ground pin of the LM122 need not necessarily be tied to system ground. It can be connected to any positive or negative voltage as long as the supply is negative with respect to the V^+ terminal. Level shifting may be necessary

for the input trigger if the trigger voltage is referred to system ground. This can be done by capacitive coupling or by actual resistive or active level shifting. One point must be kept in mind; the emitter output must not be held above the ground terminal with a low source impedance. This could occur, for instance, if the emitter were grounded when the ground pin of the LM122 was tied to a negative supply.

The terminal labeled V_{ADJ} is tied to one side of the comparator and to a voltage divider between V_{REF} and ground. The divider voltage is set at 63.2% of V_{REF} with respect to ground—exactly one RC time constant. The impedance of the divider is increased to about 30k with a series resistor to present a minimum load on external signals tied to V_{ADJ} . This resistor is a pinched type with a typical variation in absolute value of $\pm 100\%$ and a TC of 0.7%/°C. For this reason, external signals (typically a pot between V_{REF} and ground) connected to V_{ADJ} should have a source resistance as low as possible. For small changes in V_{ADJ} , up to several k Ω is all right, but for large variations 250 Ω or less should be maintained. This can be accomplished with a 1.0k pot, since the maximum impedance from the wiper is 250 Ω . If a voltage is forced on V_{ADJ} from a hard source, voltage should be limited to -0.5 , and $+5.0\text{V}$, or current limited to $\pm 1.0\text{ mA}$. This includes capacitively coupled signals because even small values of capacitors contain enough energy to degrade the input stage if the capacitor is driven with a large, fast slewing signal. The V_{ADJ} pin may be used to abort the timing cycle. Grounding this pin during the timing period causes the timer to react just as if the capacitor voltage had reached its normal RC trigger point; the capacitor discharges and the output changes state. An exception to this occurs if the trigger pin is held high when the V_{ADJ} pin is grounded. In this case, the output changes state, but the capacitor does not discharge. If the trigger drops with V_{ADJ} is being held low, discharge will occur immediately and the cycle will be over. If the trigger is still high when V_{ADJ} is released, the output may or may not change state, depending the voltage across the timing capacitor. For voltages below 2.0V across the timing capacitor, the output will change state immediately, then once more as the voltage rises past 2.0V. For voltages above 2.0V, no change will occur in the output.

In noisy environments or in comparator-type applications, a bypass capacitor on the V_{ADJ} terminal may be needed to eliminate spurious outputs because it is high impedance point. The size of the cap will depend on the frequency and energy content of the noise. A 0.1 μF will generally suffice for spike suppression, but several μF may be used if the timer is subjected to high level 60 Hz EMI.

The emitter and the collector outputs of the timer can be treated just as if they were an ordinary transistor with 40V minimum collector-emitter breakdown voltage. Normally, the emitter is tied to the ground pin and the signal is taken from the collector, or the collector is tied to V^+ and the signal is taken from the emitter. Variations on these basic connections as possible. The collector can be tied to any positive voltage up to 40V when the signal is taken from the emitter. However, the emitter will not be pulled higher than the supply voltage on the V^+ pin. Connecting the collector to a voltage less than the V^+ voltage is allowed. The emitter should not be connected to a hard source other than that to which the ground pin is tied. The transistor has built-in current limiting with a typical knee current of 120 mA. Temporary short circuits are allowed; even with collector-emitter voltages up to 40V. The power time product, however, must

not exceed 15 watt•seconds for power levels above the maximum rating of the package. A short to 30V, for instance, can not be held for more than 4 seconds. These levels are based on a 40°C maximum initial chip temperature. When driving inductive loads, always use a clamp diode to protect the transistor from inductive kick-back.

A boost pin is provided on the LM122 to increase the speed of the internal comparator. The comparator is normally operated at low current levels for lowest possible input current. For short time intervals where low input current is not needed, comparator operating current can be increased several orders of magnitude for fast operation. Shorting the boost terminal to V^+ increases the emitter current of the vertical PNP drivers in the differential stage from 25 nA to 5.0 μ A.

With the timer in the unboosted state, timing periods are accurate down to about 1 ms. In the boosted mode, loss of accuracy due to comparator speed is only about 800 ns, so timing periods of several microseconds can be used.

The "Logic" pin is used to reverse the signal appearing at the output transistor. An open or "high" condition on the logic pin programs the output transistor to be "off" during the timing period and "on" all other times. Grounding the logic pin reverses the sequence to make the transistor "on" during the timing period. Threshold for the logic is typically 150 mV with 150 μ A flowing out of the terminal. If an active drive to the logic pin is desired, a saturated transistor drive is recommended, either with a discrete transistor or the open collector output of integrated logic. A maximum V_{SAT} of 75 mV of 200 μ A is required. A typical example of active drive to the logic pin is the pulse width discriminator shown in Figure 16.

CALCULATING WORST CASE TIMING ERROR

Timing errors for the LM122 come from the following sources:

1. Timing ratio error
2. Capacitor saturation voltage
3. Internal switching delays
4. Comparator bias current
5. External resistor and capacitor tolerance
6. Capacitor and board leakage

In general, errors 1 and 5 are the most significant, so they will be treated first.

For most applications, the major contribution to timing error from the LM122 itself is variation in timing ratio, which is the ratio of the comparator threshold voltage (typically 2.0V) to the voltage at the V_{REF} pin. A 1% error in this ratio results in a 1.8% initial timing error. Timing ratio error comes from variations in the internal divider ratio and from

offset voltage in the comparator. The LM122 is specified to have a timing ratio from 0.626 to 0.638 at +25°C, giving a $\pm 1.8\%$ worst case contribution to initial timing period error. Over temperature, the worst case figures doubles to $\pm 3.6\%$. If the initial error is trimmed out externally however, timing error drift due to timing ratio will generally be less than $\pm 0.5\%$ over temperature.

Adding all the contributions to timing error from the LM122 itself will usually give a figure in the 2% to 3% range at +25°C. External timing components (R_t and C_t) will normally contribute much more error than this unless selected components are used. $\pm 5\%$ tolerance on R_t and C_t will increase the worst case error to 12% to 13%. By trimming out initial component errors, an exact initial timing period can be obtained, but temperature drift then becomes the limiting factor. For most applications, the contributions to timing period drift due to the LM122 itself will be in the 0.005%/°C to 0.02%/°C range.

If accurate timing over temperature is required, low drift components must be used for R_t and C_t . Capacitors are available with temperature coefficients of 100 to 200 ppm/°C. Resistors, at least in the lower ranges, are available with TC's much better than this. Above 1 M Ω , however, care must be used in the selection of a low TC resistor. Units are available up to 100 M Ω with less than 100 ppm/°C drift.

Capacitor saturation voltage is the voltage still remaining on the timing capacitor after it has been reset to as near ground as the internal discharge transistor can drive it. For timing resistors 1 M Ω or greater, this remaining voltage is typically 2.5 mV. For smaller timing resistors, the capacitor saturation voltage can be calculated by the following formula:

$$V_C \approx 2.5 \text{ mV} + \frac{(V_{REF}) * (80\Omega)}{R_t}$$

$$*V_{REF} = 3.15\text{V}$$

The effect of V_C on timing period is linear at 0.03%/mV. Temperature dependence of V_C is typically +0.2%/°C for $R_t \leq 300 \text{ k}\Omega$, rising to 0.4%/°C for $R_t = 10 \text{ k}\Omega$. This gives a typical temperature coefficient of timing error *due to* V_C of (0.002) (2.5 mV) (0.03%/mV) = 0.0015%/°C for $R_t \geq 1 \text{ M}\Omega$ and (0.004) (24 mV) (0.03%/mV) \approx 0.003%/°C for $R_t = 10 \text{ k}\Omega$. Since most applications can use timing resistors in the range of 100 k Ω and up, error from capacitor saturation voltage rarely exceeds 0.15% initially, with $\pm 0.05\%$ variation over the full temperature range.

Internal switching delays cause errors which tend to be a fixed time rather than a percentage of the timing period. In the boosted mode this delay is typically 800 ns, and with the boost off; the delay is about 25 μ s. These times can be

added directly to the calculated timing period for worst case analysis. For timing periods longer than 25 ms, the 25 μ s delay gives an error of 0.1% or less. In the range of 1 or 25 ms, error due to delays is 0.1% or less for the boosted mode, rising to a maximum of 4.0% in the unboosted mode. At $\tau = 10 \mu$ s, delay is the major contribution to timing error ($\approx 8\%$).

Comparator bias current contributes a negligible timing error for all but very long time timing periods. Error can be calculated with a simple formula:

$$\text{Error (\%)} = -50 \times R_t \times I_b \text{ (Note sign)}$$

I_b = Comparator Bias Current

R_t = Timing Resistor

For $R_t = 100 \text{ M}\Omega$ and $I_b = 0.3 \text{ nA}$ (typical) a 1.5% reduction in timing period is incurred. For worst case calculations at $+25^\circ\text{C}$, an I_b of 1 nA maximum is specified in the unboosted mode and 100 nA in the boosted mode. At temperatures below $+25^\circ\text{C}$, these numbers still hold. At $+125^\circ\text{C}$, I_b increases due to leakage to a maximum of $\pm 5 \text{ nA}$ unboosted. For worst case calculations below $+125^\circ\text{C}$, the leakage error (5 nA) can be assumed to halve for each 10°C drop below $+125^\circ\text{C}$. At $+95^\circ\text{C}$ for instance, the leakage component of I_b would be (5 nA/8) $\approx 0.6 \text{ nA}$ for a total I_b of 1.6 nA worst case. For the commercial LM322 and LM3905, worst case I_b is 2 nA at $+75^\circ\text{C}$, and for the LM2905 I_b is 2 nA maximum at $+85^\circ\text{C}$. For temperatures between -25°C and $+85^\circ\text{C}$, the TC of I_b is typically 5 pA/ $^\circ\text{C}$ in the unboosted mode and 100 pA/ $^\circ\text{C}$ in the boosted mode. For a 100 M Ω R_t , this 5 pA/ $^\circ\text{C}$ contributes $-0.025\%/^\circ\text{C}$ to timing period drift.

$$\text{Error (\%/}^\circ\text{C)} = (-50) (\Delta I_b / \Delta T) (R_t)$$

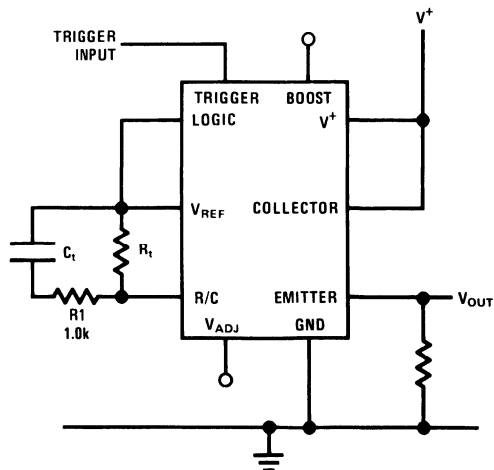
For worst case calculations a $\Delta I_b / \Delta T$ ($-25 \leq T_A \leq +85^\circ\text{C}$) of 12 pA/ $^\circ\text{C}$ may be used for the LM122/LM222 and 20 pA/ $^\circ\text{C}$ for the LM322 and LM2905/LM3905.

External leakage paths may cause timing errors for large values of R_t and high board temperatures. Connections made to the R/C pin should be kept free of dust, moisture, and soldering flux if long time intervals are to be kept accurate. All package types have the R/C pin located between V_{REF} and the ground pin to minimize these leakages.

DESIGN HINTS

ELIMINATING TIMING CYCLE UPON INITIAL APPLICATION OF POWER

The LM122 will start a timing cycle automatically (with no trigger input) when V^+ is first turned on. If this characteristic is undesirable, it can be defeated by tying the timing capacitor to V_{REF} instead of ground as shown in Figure 2. This connection does not affect operation of the timer in any other way. If an electrolytic timing capacitor is used, be sure the negative end is tied to the R/C pin and the positive end to V_{REF} . A 1.0 k Ω resistor should be included in series with the timing capacitor to limit the surge current load on V_{REF} when the capacitor is discharged.



TL/H/7408-2

FIGURE 2. Eliminating Initial Timing Cycle

USING ELECTROLYTIC TIMING CAPACITORS

Electrolytic capacitors are not usually recommended for timing because of their unstable capacitance and high leakage. For long timing periods (> 10 seconds) at moderate temperatures (0°C to 50°C) however, an electrolytic may be attractive because of its low cost per microfarad. Solid tantalum capacitors such as the Kemet[®] C series T310 (molded epoxy) or T110 (hermetic) are recommended. These units have long term stabilities of 2% to 3% and a temperature coefficient of $+0.2\%/^\circ\text{C}$. Selected units are available for timing use with very low leakage.

RESET TIME

The timing capacitor used with the LM122 is reset with an internal transistor which has a collector offset voltage of 2.5 mV @ 1 μ A with approximately 80 Ω of collector resistance. The time required to reset this capacitor determines the minimum time between timing pulses. An approximate formula for reset time is:

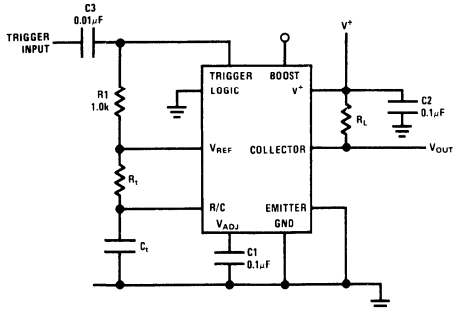
$$\text{Reset Time} = (80\Omega) (C_t^{\dagger}) (5)$$

$^{\dagger}C_t$ = External timing capacitor.

NOISY ENVIRONMENTS

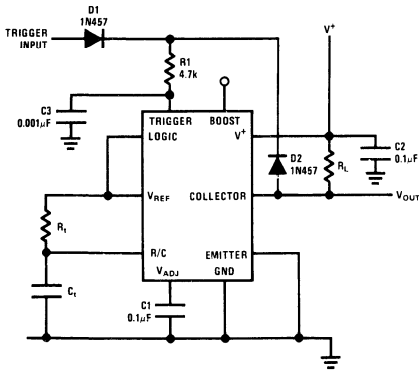
The LM122 is relatively insensitive to noise on supply lines and to radiated energy. In *extremely* noisy environments however, it may be necessary to configure the LM122 differently, both to eliminate false triggering and to prevent premature end of a timing period. The circuit "a" shown in Figure 3 has been set up for maximum noise rejection. C1 bypasses the V_{ADJ} pin because of the relatively high impedance ($\approx 30 \text{ k}\Omega$) of this point. Negative spikes on the V_{ADJ} pin will cause premature end of the timing period. C2 bypasses the supply for rejection of fast transients. R1 sets up the trigger pin to a "normally high" condition. This prevents extremely high electromagnetic fields from triggering the internal flip-flop during a timing period. The input trigger signal is capacitively coupled through C3. Triggering occurs on the *negative* edge of the trigger pulse as shown in the waveform sketch next to Figure 21.

If the output voltage from the LM122 can be set up to go "high" during the timing cycle, the alternate connection shown in "b" can be used. Here, the trigger is held high by D2 during the timing period. When the output goes low after the timing period is over, the circuit may be retriggered immediately via D1. R1 and C3 suppress unwanted spikes at the trigger input.



TL/H/7408-3

(A)



TL/H/7408-4

(B)

FIGURE 3. Maximum Noise Immunity

ABORTING A TIMING CYCLE (Figure 4)

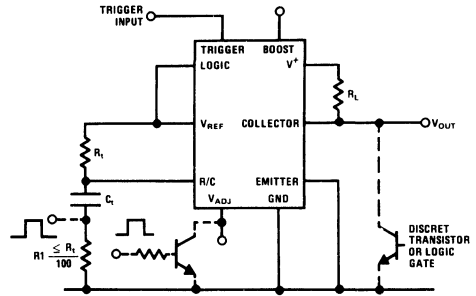
The LM122 does not have an input specifically allocated to a stop-timing function. If such a function is desired, it may be accomplished several ways:

- Ground V_{ADJ}
- Raise R/C more positive than V_{ADJ}
- Wire "OR" the output

Grounding V_{ADJ} will end the timing cycle just as if the timing capacitor had reached its normal discharge point. A new timing cycle can be started by the trigger terminal as soon as the ground is released. A switching transistor is best for driving V_{ADJ} to as near ground as possible. Worst case sink current is about 300 μ A.

A timing cycle may be also ended by a positive pulse to a resistor ($R \leq R_T/100$) in series with the timing capacitor.

The pulse amplitude must be at least equal to V_{ADJ} (2.0V), but should not exceed 5.0V. When the timing capacitor discharges, a negative spike of up to 2.0V will occur across the resistor, so some caution must be used if the drive pulse is used for other circuitry.



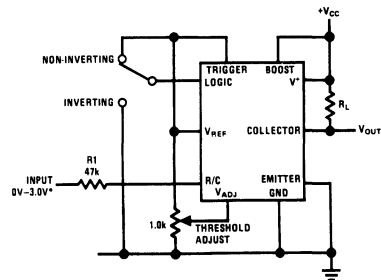
TL/H/7408-5

FIGURE 4. Cycle Interrupt

The output of the timer can be wire ORed with a discrete transistor or an open collector logic gate output. This allows overriding of the timer output, but does not cause the timer to be reset until its normal cycle time has elapsed.

USING THE LM122 AS A COMPARATOR

A built-in reference and zero volt common mode limit make the LM122 very useful as a comparator. Threshold may be adjusted from zero to three volts by driving the V_{ADJ} terminal with a divider tied to V_{REF} . Stability of the reference voltage is typically $\pm 1\%$ over a temperature range of -55°C to $+125^\circ\text{C}$. Offset voltage drift in the comparator is typically $25 \mu\text{V}/^\circ\text{C}$ in the boosted mode and $50 \mu\text{V}/^\circ\text{C}$ unboosted. A resistor can be inserted in series with the input to allow overdrives up to $\pm 50\text{V}$ as shown in Figure 5. There is actually no limit on input voltage as long as current is limited to



TL/H/7408-6

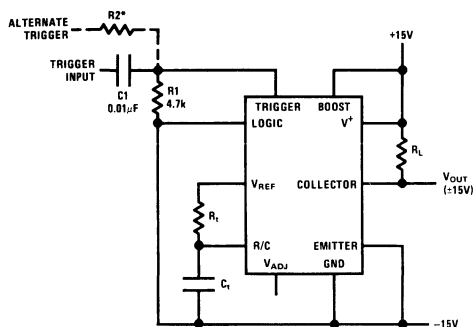
*Timer Protected Against Damage for Up to $\pm 50\text{V}$

FIGURE 5. Comparator with 0 Volts to 3.0 Volts Threshold

$\pm 1 \text{ mA}$. The resistor shown contributes a worst case of 5 mV to initial offset. In the unboosted mode, the error drops to 0.25 mV maximum. The capability of operating off a single 5V supply should make this comparator very useful.

USING DUAL SUPPLIES

The LM122 can be operated off dual supplies as shown in Figure 6. The only limitation is that the emitter terminal cannot be tied to ground, it must either drive a load referred to V^- or be actually tied to V^- as shown. Although capacitive coupling is shown for the trigger input (to allow 5V triggering), a resistor can be substituted for C1. R2 must be chosen to give proper level shifting between the trigger signal and the trigger pin of the timer. Worst case "10" on the trigger pin (with respect to V^-) is 0.8V, and worst case "high" is 2.5V. R2 may be calculated from the divider equation with R1 to give these levels.

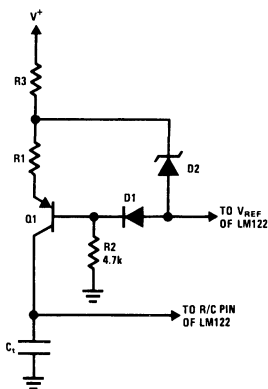


*Select For Proper Level Shift
Emitter Terminal Or Emitter Load Must Be Tied To GND Pin Of Timer.

FIGURE 6. Operating Off Dual Supplies

LINEARIZING THE CHARGING SWEEP

In some applications (such as a linear pulse width modulator) it may be desirable to have the timing capacitor charge from a constant current source. A simple way to accomplish this is shown in the accompanying sketch.



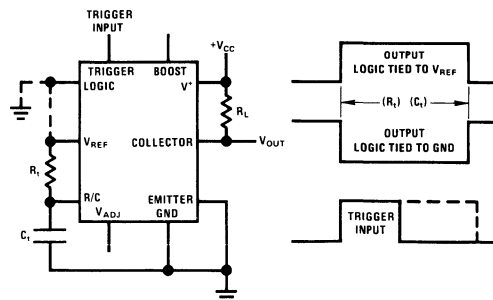
TL/H/7408-8

Q1 converts the current through R1 to a current source independent of the voltage across C_t . R2, R3, D1, and D2 are added to make the current through R1 independent of supply variations and temperature changes. (D2 is a low TC type) D2 and R3 can be omitted if the V^+ supply is stable and D1 and R2 can be omitted also if temperature stability is not critical. With D1 and R2 omitted, the current through R1 will change about 0.015%/°C with a 15V supply and 0.1%/°C with a 5.0V supply.

APPLICATIONS

BASIC TIMERS

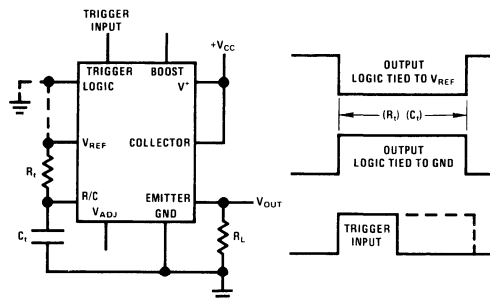
Figure 7 is a basic timer using the collector output. R_t and C_t set the time interval with R_L as the load. During the timing interval the output may be either high or low depending on the connection of the logic pin. Timing waveforms are shown in the sketch alongside Figure 7.



TL/H/7408-9

FIGURE 7. Basic Timer-Collector Output and Timing Chart

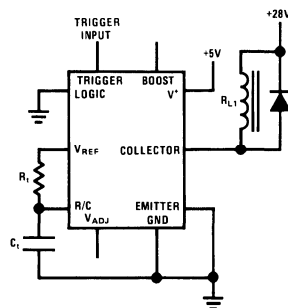
Figure 8 is again a basic timer, but with the output taken from the emitter of the output transistor. As with the collector output, either a high or low condition may be obtained during the timing period.



TL/H/7408-10

FIGURE 8. Basic Timer-Emitter Output and Timing Chart

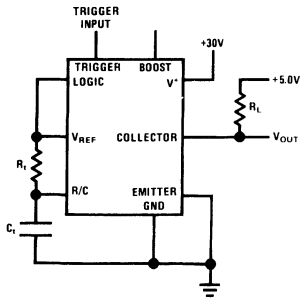
Figure 9 shows the timer interfacing 5V logic to a high voltage relay. Although the V^+ terminal could be tied to the +28V supply, this would be an unnecessary waste of power in the IC. In any case, the threshold for the trigger is 1.6V regardless of where V^+ is tied.



TL/H/7408-11

FIGURE 9. 5 Volt Logic Supply Driving 28 Volt Relay

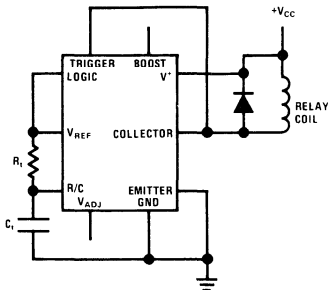
Figure 10 indicates the ability of the timer to interface to digital logic when operating off a high supply voltage. V_{OUT} swings between +5V and ground with a minimum fanout of 5 for medium speed TTL.



TL/H/7408-12

FIGURE 10. 30 Volt Supply Interfacing to 5 Volt Logic

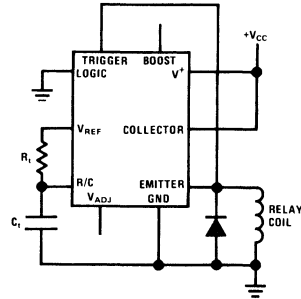
Figure 11 is an application where the LM122 is used to simulate a thermal delay relay which prevents power from being applied to other circuitry until the supply has been on for



TL/H/7408-13

FIGURE 11. Time Out on Power Up (Relay Energized $R_t C_t$ Seconds After V_{CC} is Applied)

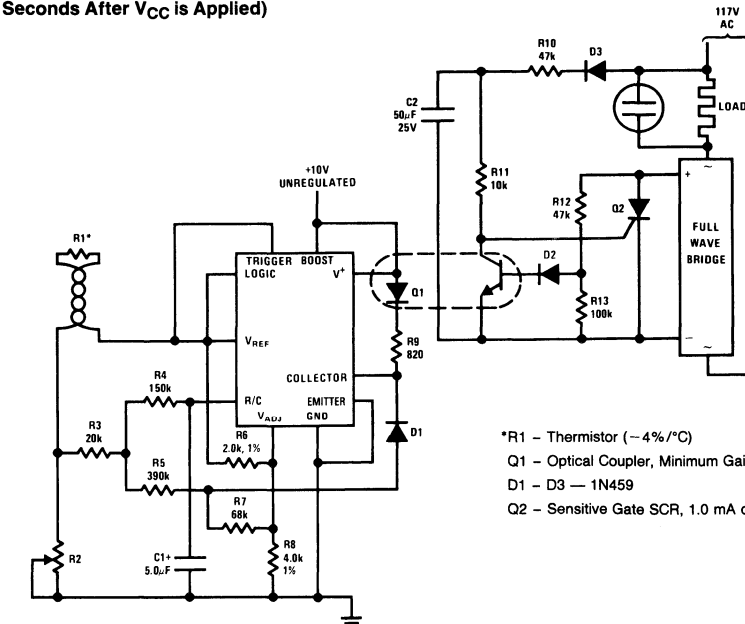
some time. The relay remains de-energized for $R_t C_t$ seconds after V_{CC} is applied, then closes and stays energized until V_{CC} is turned off. Figure 12 is a similar circuit except that the relay is energized as soon as V_{CC} is applied. $R_t C_t$ seconds later, the relay is de-energized and stays off until the V_{CC} supply is recycled.



TL/H/7408-14

FIGURE 12. Time Out on Power Up (Relay Energized Until $R_t C_t$ Seconds After V_{CC} is Applied)

Figure 13 is a more advanced application of the LM122 as a proportioning temperature controller with optical isolation and synchronized zero crossing features. The timing function is not used. Instead the trigger terminal is held high and the LM122 is used as a high gain comparator with a built in reference. R1 is a thermistor with a $-4\%/^{\circ}\text{C}$ temperature coefficient used as the sensor. R2 is used to set the temperature to be controlled by R1. R3 through R8 set up the proportioning action. R3 raises the impedance of the R_1/R_2 divider so that R5 sees a relatively constant impedance independent of the set point temperature. R6 and R8 reduce the V_{ADJ} impedance so that internal variations in divider impedance do not affect proportioning action. R5 and R7



- *R1 - Thermistor ($-4\%/^{\circ}\text{C}$)
- Q1 - Optical Coupler, Minimum Gain = $\frac{1}{2}$ at 1.0 mA
- D1 - D3 - 1N459
- Q2 - Sensitive Gate SCR, 1.0 mA or Less

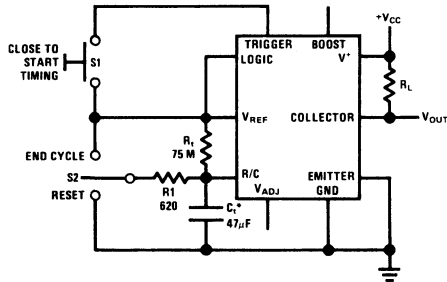
TL/H/7408-15

FIGURE 13. Proportioning Temperature Controller with Synchronized Zero-Crossing

set the actual width of the proportioning band and can be scaled as necessary to alter the width of the band. Larger resistors make the band narrower. The values shown give approximately a 1°C band. R4 and C1 determine the proportioning frequency which is about 1 Hz with the values shown. C1 or R4 can change to alter frequency, but R4 should be between 50k and 500k, and C1 must be a low leakage type to prevent temperature shifts. D1 prevents supply voltage fluctuations from affecting set point or proportioning band. Any unregulated supply between 6V and 15V is satisfactory.

Q1 is an optical isolator with a minimum gain of 0.5. With the values shown for R9, R10, and R11, Q1 is over-driven by at least 3 to 1 to insure deep saturation for reliable turn off of the SCR. Q2 must be a sensitive gate device with a worst case gate firing current of 0.5 mA. R12, R13, and D2 implement the synchronized zero-crossing feature by preventing Q1 from turning off after the voltage across Q2 has climbed above 2.5V. D3, R10, and C2 provide a source of semifermented dc current must have a minimum breakdown of 200V.

Figure 14 shows the LM122 connected as a one hour timer with manual controls for start, reset, and cycle end. S1 starts timing, but has no effect after timing has started. S2 is a center off switch which can either end the cycle pre-

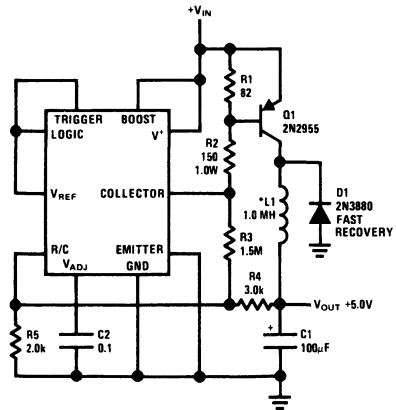


*Dearborn Electronics LP9A1A476K Polycarbonate TL/H/7408-16

FIGURE 14. One Hour Timer with Reset and Manual Cycle End

turely with the appropriate change in output state and discharging of C_t, or cause C_t to be reset to 0V without a change in output. In the latter case, a new timing period starts as soon as S2 is released. The average charging current through R_t is about 30 nA, so some attention must be paid to parts layout to prevent stray leakage paths. The suggested timing capacitor has a typical self time constant of 300 hours and a guaranteed minimum of 25 hours at +25°C. Other capacitor types may be used if sufficient data is available on their leakage characteristics.

Figure 15 is another application where the LM122 does not use its timing function. A switching regulator is made using the internal reference and comparator to drive a PNP switch transistor. Features of this circuit include a 5.5V minimum input voltage at 1A output current, low part count, and good efficiency (> 75%) for input voltages to 10V. Line and load regulation are less than 0.5% and output ripple at the switching frequency is only 30 mV. Q1 is an inexpensive plastic device which does not need a heatsink for ambient temperature up to 50°C. D1 should be a fast switching diode. Output voltage can be adjusted between 1V and 30V by choosing proper values for R2, R3, R4, and R5. For outputs less than 2V, a divider with 250Ω Thevinin resist-

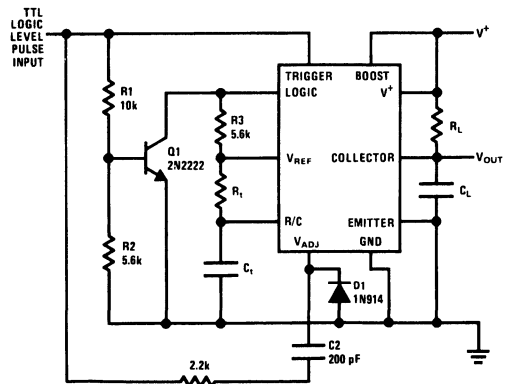


*No. 22 Wire Wound On Molybdenum Permalloy Core TL/H/7408-17

FIGURE 15. 5 Volt Switching Regulator with 1.0 Amp Output and 5.5 Volt Minimum Input

ance must be connected between V_{REF} and ground with its tap point tied to V_{ADJ}.

By driving the logic terminal of the LM122 simultaneously to the trigger input, a simple, accurate pulse width detector can be made (Figure 16).



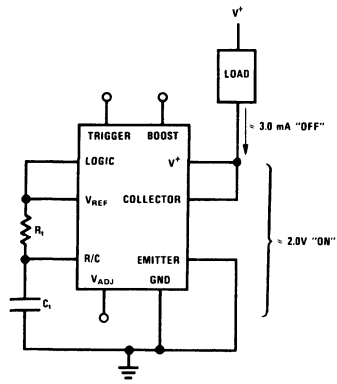
*V_{OUT} = 0 For W < R_t C_t TL/H/7408-18

Pulse Out = W - R_t C_t For W > R_t C_t

FIGURE 16. Pulse Width Detector

In this application the logic terminal is normally held high by R3. When a trigger pulse is received, Q1 is turned on, driving the logic terminal to ground. The result of triggering the timer and reversing the logic at the same time is that the output does not change from its initial low condition. The only time the output will change states is when the trigger input stays high longer than one time period set by R_t and C_t. The output pulse width is equal to the input trigger width minus R_t * C_t. C2 insures no output pulse for short (< RC) trigger pulses by prematurely resetting the timing capacitor when the trigger pulse drops. C_L filters the narrow spikes which would occur at the output due to interval delays during switching.

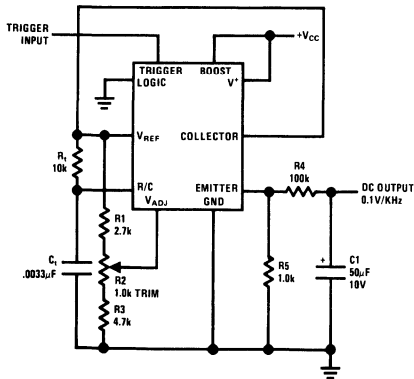
The LM122 can be used as a two terminal time delay switch if an "on" voltage drop of 2V to 3V can be tolerated. In



TL/H/7408-19

FIGURE 17. Two-Terminal Time Delay Switch

Figure 17, the timer is used to drive a relay "on" R_1 C_1 seconds after application of power "off" current of the switch is 4 mA maximum, and "on" current can be as high as 50 mA. An accurate frequency to voltage converter can be made with the LM122 by averaging output pulses with a simple one pole filter as shown in Figure 18. Pulse width is adjusted with R_2 to provide initial calibration at 10 kHz. The collector of the output transistor is tied to V_{REF} , giving constant amplitude pulses equal to V_{REF} at the emitter output. R_4 and C_1 filter the pulses to give a dc output equal to, $(R_1) (C_1) (V_{REF}) (f)$. Linearity is about 0.2% for a 0V to 1V output. If better linearity is desired R_5 can be tied to the summing node of an op amp which has the filter in the feedback path. If a low output impedance is desired, a unity gain buffer such as the LM110 can be tied to the output. An analog meter can be driven directly by placing it in series with R_5 to ground. A series RC network across the meter to provide damping will improve response at very low frequencies.

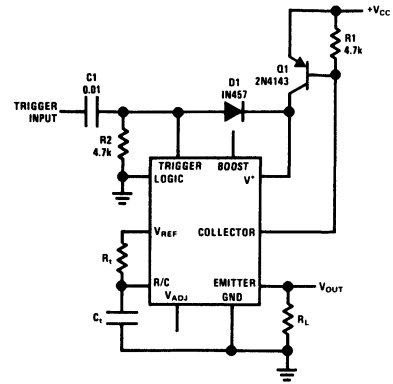


TL/H/7408-20

FIGURE 18. Frequency to Voltage Converter (Tachometer) Output Independent of Supply Voltage

In some applications it is desirable to reduce supply drain to zero between timing cycles. In Figure 19 this is accomplished by using an external PNP as a latch to drive the V^+ pin of the timer.

Between timing periods Q_1 is off and no supply current is drawn. When a trigger pulse of 5V minimum amplitude is

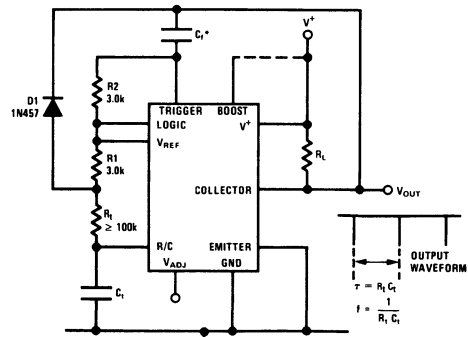


TL/H/7408-21

FIGURE 19. Zero Power Dissipation Between Timing Intervals

received, the LM122 output transistor and Q_1 latch for the duration of the timing period. D_1 prevents coupling back into the trigger signal from the dc load created by the trigger input. If the trigger input is a short pulse, C_1 and R_2 may be eliminated. R_L must have a minimum value of $(V_{CC})/(2.5 \text{ mA})$.

The LM122 can be made into a self-starting oscillator by feeding the output back to the trigger input through a capac-



*See Chart

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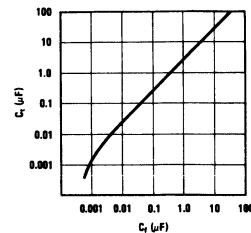


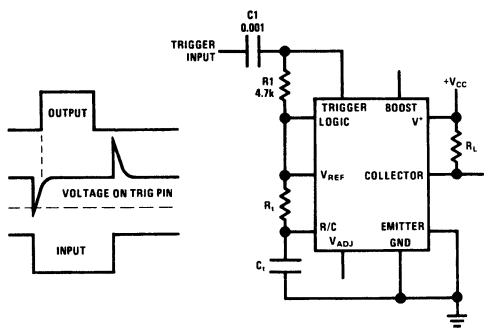
FIGURE 20. Oscillator

itor as shown in Figure 20. Operating frequency is $1/(R_1 C_1)$. The output is a narrow negative pulse whose width is approximately $2R_2 C_1$. For optimum frequency stability, C_1 should be as small as possible. The minimum value is determined by the time required to discharge C_1 through the internal discharge transistor. A conservative value for C_1 can be

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chosen from the graph included with *Figure 20*. For frequencies below 1 kHz, the frequency error introduced by C_t is a few tenths of one percent or less for $R_t > 500k$.

Although the LM122 is triggered by a positive going trigger signal, a differentiator tied to a normally "high" trigger will result in negative edge triggering. In *Figure 21*, R_1 serves



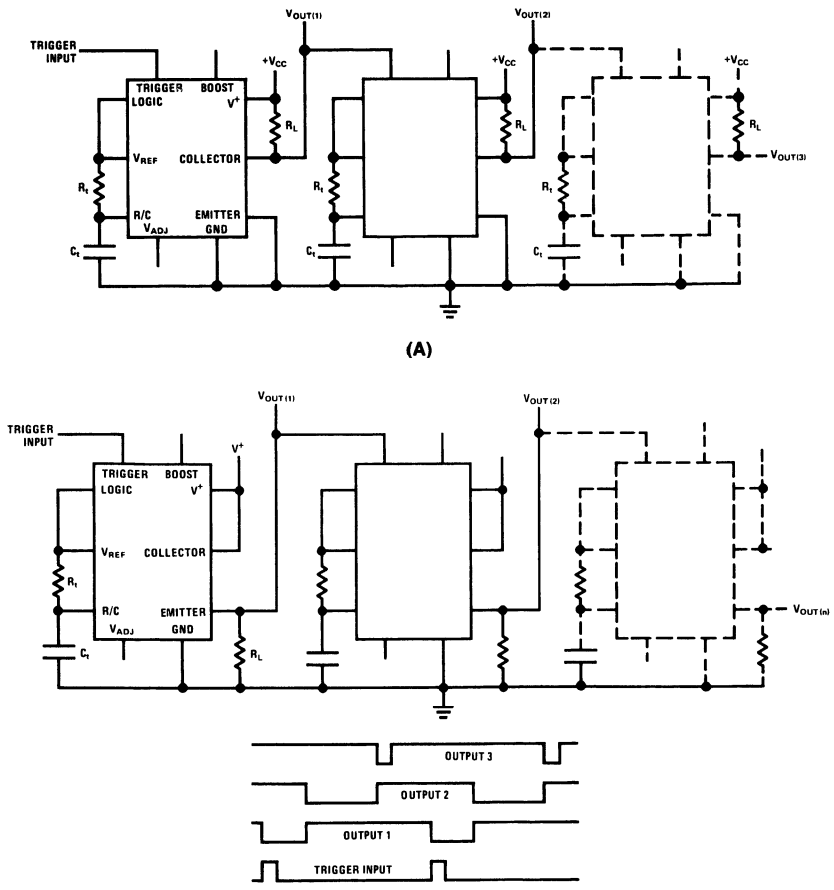
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FIGURE 21. Timer Triggered by Negative Edge of Input Pulse

the dual purpose of holding the trigger pin normally high and differentiating the input trigger pulse coupled through C_1 . The timing diagram included with *Figure 21* shows that triggering actually occurs a short time after the negative going trigger, while positive going triggers have no effect. The delay time between a negative trigger signal and actual starts of timing is approximately 0.5 to 1.5 $R_1 C_1$ depending on the trigger amplitude, or about 2.5 to 7.5 μs with the values shown. This time will have to be increased for C_t larger than 0.01 μF because C_t is charged to V_{REF} whenever the trigger pin is kept high and must reset itself during the short time that the trigger pin voltage is low. A conservative value for C_1 is:

$$C_1 \geq \frac{C_t}{10}$$

The LM122 can be connected as a chain of timers quite easily with no interface required. In *Figure 22A* and *22B*, two possible connections are shown. In both cases, the output of the timer is low during the timing period so that the positive going signal at the end of timing period can trigger the next timer. There is no limitation on the timing period of one timer with respect to any other timer before or after it, because the trigger input to any timer can be high or low when that timer ends its timing period.



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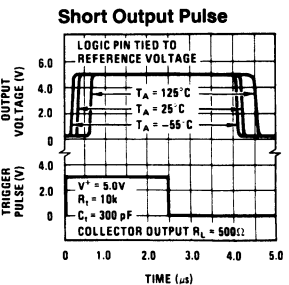
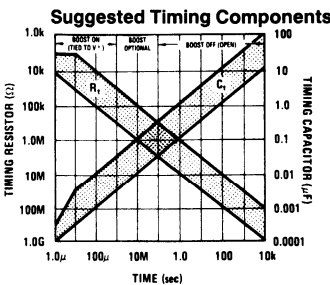
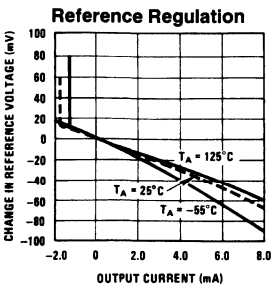
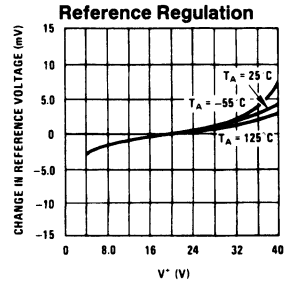
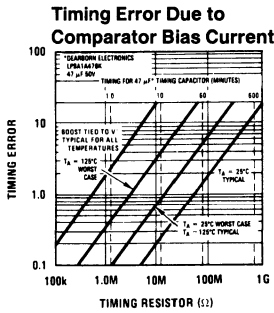
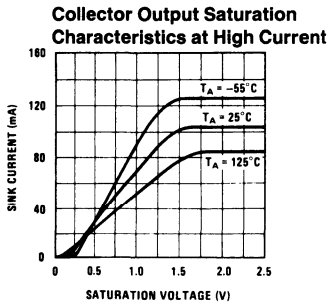
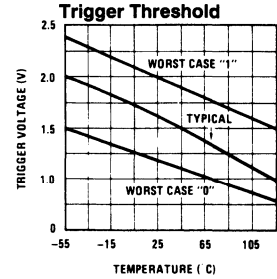
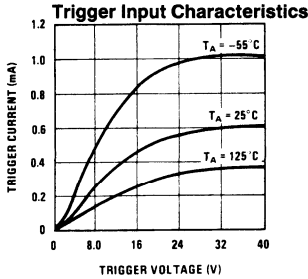
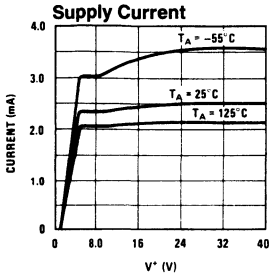
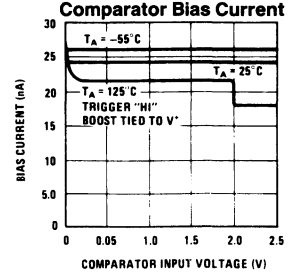
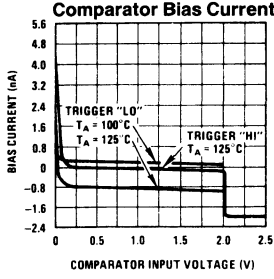
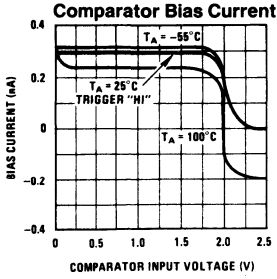
(A)

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(B)

FIGURE 22. Chain of Timers

Typical Performance Characteristics



TL/H/7408-27

LM340 Series Three Terminal Positive Regulators

National Semiconductor
Application Note 103
Nello Sevastopoulos
George Cleveland
Jim Sherwin



INTRODUCTION

The LM340-XX are three terminal 1.0A positive voltage regulators, with preset output voltages of 5.0V or 15V. The LM340 regulators are complete 3-terminal regulators requiring no external components for normal operation. However, by adding a few parts, one may improve the transient response, provide for a variable output voltage, or increase the output current. Included on the chip are all of the functional blocks required of a high stability voltage regulator; these appear in *Figure 1*.

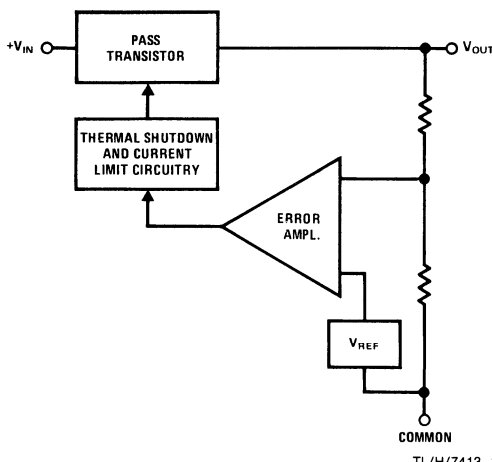


FIGURE 1. Functional Block of the LM340

The error amplifier is internally compensated; the voltage reference is especially designed for low noise and high predictability; and, as the pass element is included, the regulator contains fixed current limiting and thermal protection. The LM340 is available in either metal can TO-3 or plastic TO-220 package.

1. CIRCUIT DESIGN

Voltage Reference

Usually IC voltage regulators use temperature-compensated zeners as references. Such zeners exhibit $BV > 6.0V$ which sets the minimum supply voltage somewhat above 6.0V. Additionally they tend to be noisy, thus a large bypass capacitor is required.

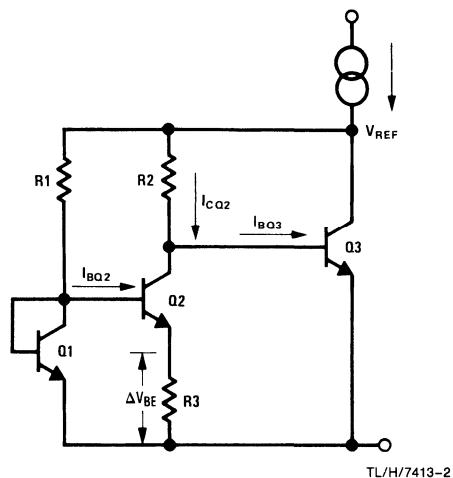


FIGURE 2. Simplified Volt Reference

Figure 2 illustrates a simplified reference using the predictable temperature, voltage, and current relationship of emitter-base junctions.

Assuming $J_{Q1} > J_{Q2}$, $I_{CQ2} \gg I_{BQ2} = I_{BQ3}$,
Area (emitter Q1) = Area (emitter Q2), and

$$V_{BEQ1} = V_{BEQ3} \quad (1-1)$$

then

$$V_{REF} \approx \left(\frac{kT}{q} \ln \frac{R_2}{R_1} \right) \frac{R_2}{R_3} + V_{BEQ3} \quad (1-2)$$

Simplified LM340

In *Figure 3* the voltage reference includes R1-R3 and Q1-Q5. Q3 also acts as an error amplifier and Q6 as a buffer between Q3 and the current source. If the output drops, this drop is fed back, through R4, R5, Q4, Q5, to the base of Q3. Q7 then conducts more current re-establishing the output given by:

$$V_{OUT} = V_{REF} \frac{R_4 + R_5}{R_4}$$

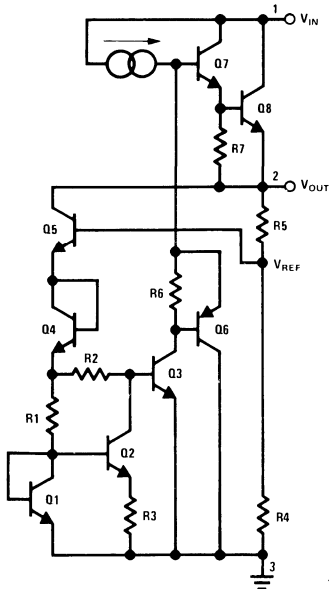


FIGURE 3. LM340 Simplified

TL/H/7413-3

Complete Circuit of the LM340 (Figure 4)

Here $(J_{Q2}, J_{Q3}) > (J_{Q4}, J_{Q5})$ and a positive $TC \Delta V_{BE}$ appears across $R6$. This is amplified by 17, $(R6/R6 = 17)$ and is temperature compensated by the V_{BE} of $Q6, Q7, Q8$ to develop the reference voltage. $R17$ is changed to get the various fixed output voltages.

Short Circuit Protection

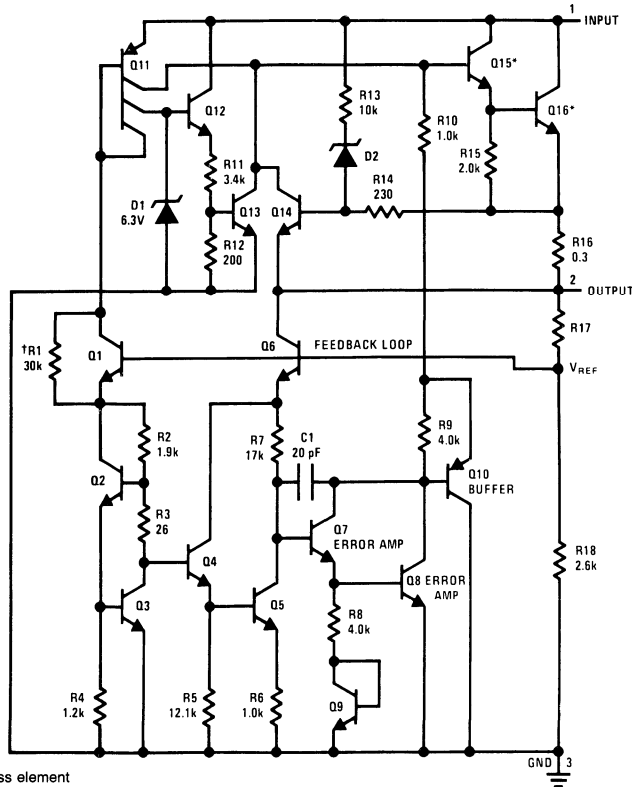
A) $V_{IN} - V_{OUT} < 6.0V$: There is no current through $D2$ and the maximum output current will be given by:

$$I_{OUT MAX} = \frac{V_{BEQ14}}{R16} \cong 2.2A \quad (T_j = 25^\circ C) \quad (1-4)$$

B) $V_{IN} - V_{OUT} > 6.0V$: To keep $Q16$ operating within its maximum power rating the output current limit must decrease as $V_{IN} - V_{OUT}$ increases. Here $D2$ conducts and the drop across $R16$ is less than V_{BE} to turn on $Q14$. In this case I_{OUT} maximum is:

$$I_{OUT MAX} = \int \frac{1}{R16} \left(V_{BEQ14} - \frac{[(V_{IN} - V_{OUT}) - V_{ZD2} - V_{BEQ14}]}{R13} R14 \right) \quad (1-5)$$

at $T_j = 25^\circ C$



*Series pass element

†Starting up resistor

FIGURE 4. Complete Circuit of the LM340

TL/H/7413-4

Thermal Shut Down

In Figure 4 the V_{BE} of Q13 is clamped to 0.4V. When the die temperature reaches approximately +175°C the V_{BE} to turn on Q13 is 0.4V. When Q13 turns on it removes all base drive from Q15 which turns off the regulator thus preventing a further increase in die temperature.

Power Dissipation

The maximum power dissipation of the LM340 is given by:

$$P_{D\text{ MAX}} = (V_{IN\text{ MAX}} - V_{OUT}) I_{OUT\text{ MAX}} + V_{IN\text{ MAX}} I_Q \text{ (W)} \quad (1-6)$$

The maximum junction temperature (assuming that there is no thermal protection) is given by:

$$T_{JM} = \frac{36 - 13 I_{OUT\text{ MAX}} - (V_{IN} - V_{OUT})}{0.0855} + 25^\circ\text{C} \quad (1-7)$$

Example:

$$V_{IN\text{ MAX}} = 23\text{V}, I_{OUT\text{ MAX}} = 1.0\text{A}, \text{LM340T-15.}$$

Equation (1-7) yields: $T_{JM} = 200^\circ\text{C}$. So the T_J max of 150°C specified in the data sheet should be the limiting temperature.

From (1-6) $P_D \approx 8.1\text{W}$. The thermal resistance of the heat sink can be estimated from:

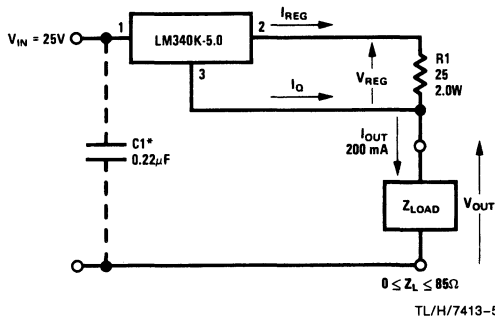
$$\theta_{s-a} = \frac{T_{JM\text{ MAX}} - T_A}{P_D} - (\theta_{j-c} + \theta_{c-s}) \text{ (}^\circ\text{C/W)} \quad (1-8)$$

The thermal resistance θ_{j-c} (junction to case) of the TO-220 package is 6°C/W, and assuming a θ_{c-s} (case to heat sink) of 0.4, equation (1-8) yields:

$$\theta_{s-a} = 8.4^\circ\text{C/W}$$

2. CURRENT SOURCE

The circuit shown on Figure 5 provides a constant output current (equal to V_{OUT}/R_1 or 200 mA) for a variable



*Required if regulator is located far from power supply filter

FIGURE 5. Current Source

load impedance of 0 to 85Ω. Using the following definitions and the notation shown on Figure 5, Z_{OUT} and I_{OUT} are:

Q_{CC}/V = Quiescent current change per volt of input/output (pin 1 to pin 2) voltage change of the LM340

L_r/V = Line regulation per volt: the change in the LM340 output voltage per volt of input/output voltage change at a given I_{OUT} .

$$\Delta I_{OUT} = (Q_{CC}/V) \Delta V_{OUT} + \frac{L_r/V}{R_1} \Delta V_{OUT} \quad (2-1)$$

$$Z_{OUT} = \frac{\Delta V_{OUT}}{\Delta I_{OUT}} \quad (2-2)$$

$$Z_{OUT} = \frac{\Delta V_{OUT}}{(Q_{CC}/V) \Delta V_{OUT} + \frac{(L_r/V)}{R_1} \Delta V_{OUT}} \quad (2-3)$$

$$Z_{OUT} = \frac{1}{(Q_{CC}/V) + \frac{(L_r/V)}{R_1}} \quad (2-4)$$

The LM340-5.0 data sheet lists maximum quiescent current change of 1.0 mA for a 7.0V to 25V change in input voltage; and a line regulation (interpolated for $I_{OUT} = 200$ mA) of 35 mV maximum for a 7.0V to 25V change in input voltage:

$$Q_{CC}/V = \frac{1.0\text{ mA}}{15\text{V}} = 55\text{ }\mu\text{A/V} \quad (2-5)$$

$$L_r/V = \frac{35\text{ mV}}{18\text{V}} \approx 2\text{ mV/V} \quad (2-6)$$

The worst case change in the 200 mA output current for a 1.0V change in output or input voltage using equation 2-1 is:

$$\frac{\Delta I_{OUT}}{1.0\text{V}} = 55\text{ }\mu\text{A} + \frac{2\text{ mV}}{25\Omega} = 135\text{ }\mu\text{A} \quad (2-7)$$

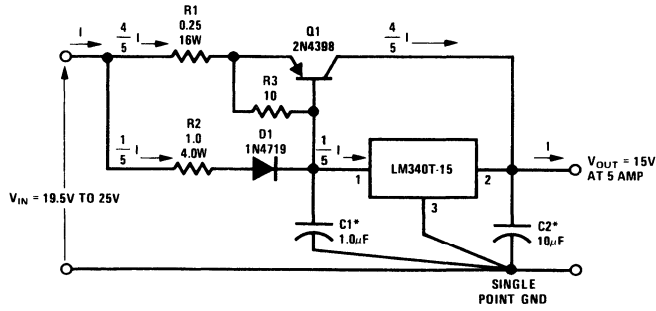
and the output impedance for a 0 to 85Ω change in Z_L using equation 2-4 is:

$$Z_{OUT} = \frac{1}{55\text{ }\mu\text{A} + \frac{2\text{ mV}}{25\Omega}} = 7.4\text{ k}\Omega \quad (2-8)$$

Typical measured values of Z_{OUT} varied from 10–12.3 kΩ, or 81–100 $\mu\text{A/V}$ change input or output (approximately 0.05%/V).

3. HIGH CURRENT REGULATOR WITH SHORT CIRCUIT CURRENT LIMIT

The 15V regulator circuit of Figure 6 includes an external boost transistor to increase output current capability to 5.0A. Unlike the normal boosting methods, it maintains the LM340's ability to provide short circuit current limiting and thermal shut-down without use of additional active components. The extension of these safety features to the external pass transistor Q1 is based on a current sharing scheme



*Solid tantalum

Note 1: Current sharing between the LM340 and Q1 allows the extension of short circuit current limit, safe operating area protection, and (assuming Q1's heat sink has four or more times the capacity of the LM340 head sink) thermal shutdown protection.

Note 2: I_{SHORT CIRCUIT} is approximately 5.5 amp.

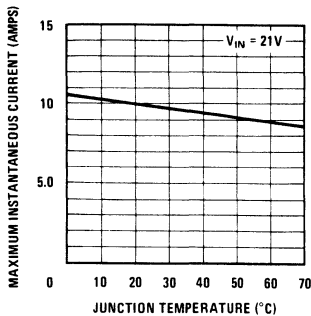
Note 3: I_{OUT MAX} at V_{OUT} = 15V is approximately 9.5 amp.

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FIGURE 6. 15V 5.0A Regulator with Short Circuit Current Limit

using R1, R2, and D1. Assuming the base-to-emitter voltage of Q1 and the voltage drop across D1 are equal, the voltage drops across R1 and R2 are equal. The currents through R1 and R2 will then be inversely proportional to their resistances. For the example shown in *Figure 6*, resistor R1 will have four times the current flow of R2. For reasonable values of Q1 beta, the current through R1 is approximately equal to the collector current of Q1; and the current through R2 is equal to the current flowing through the LM340. Therefore, under overload or short circuit conditions the protection circuitry of the LM340 will limit its own output current and, because of the R1/R2 current sharing scheme, the output current of Q1 as well. Thermal overload protection also extends Q1 when its heat sink has four or more times the capacity of the LM340 heat sink. This follows from the fact that both devices have approximately the same input/output voltage and share the load current in a ratio of four to one.

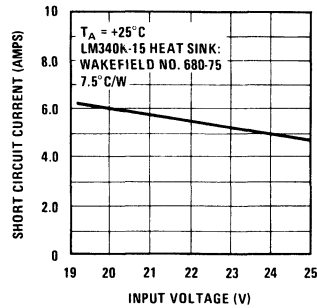
The circuit shown on *Figure 6* normally operates at up to 5.0A of output current. This means up to 1.0A of current flows through the LM340 and up to 4.0A flows through Q1. For short term overload conditions the curve of *Figure 7* shows the maximum instantaneous output current versus temperature for the boosted regulator. This curve reflects the approximately 2.0A current limit of the LM340 causing an 8.0A current limit in the pass transistor, or 10A, total.



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FIGURE 7. Maximum Instantaneous Current vs Junction Temperature

Under continuous short circuit conditions the LM340 will heat up and limit to a steady total state short circuit current of 4.0A to 6.0A as shown in *Figure 8*. This curve was taken using a Wakefield 680-75 heat sink (approximately 7.5°C/W) at a 25°C ambient temperature.

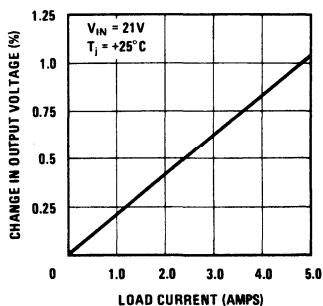


TL/H/7413-8

FIGURE 8. Continuous Short Circuit Current vs Input Voltage

For optimum current sharing over temperature between the LM340 and Q1, the diode D1 should be physically located close to the pass transistor on the heat sink in such a manner as to keep it at the same temperature as that of Q1. If the LM340 and Q1 are mounted on the same heat sink the LM340 should be electrically isolated from the heat sink since its case (pin 3) is at ground potential and the case of Q1 (its collector) is at the output potential of the regulator. Capacitors C1 and C2 are required to prevent oscillations and improve the output impedance respectively. Resistor R3 provides a path to unload excessive base charge from the base of Q1 when the regulator goes suddenly from full load to no load. The single point ground system shown on *Figure 6* allows the sense pins (2 and 3) of the LM340 to monitor the voltage directly at the load rather than at some point along a (possibly) resistive ground return line carrying up to 5.0A of load current. *Figure 9* shows the typical variation of load regulation versus load current for the boosted regulator. The insertion of the external pass transistor increases the input/output differential voltage from 2.0V to

approximately 4.5V. For an output current less than 5.0A, the R2/R1 ratio can be set lower than 4:1. Therefore, a less expensive PNP transistor may be used.



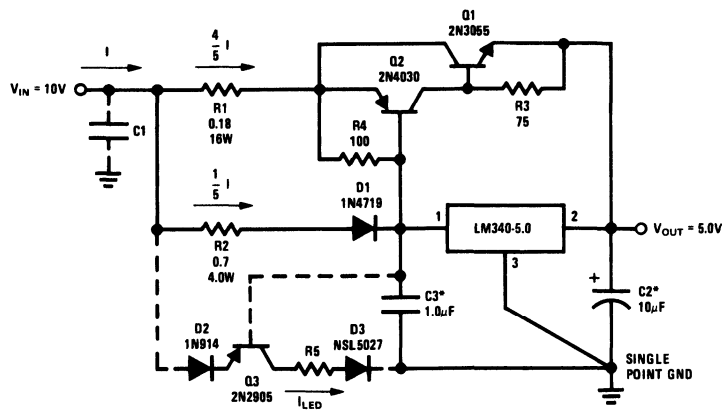
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FIGURE 9. Load Regulation

4. 5.0V, 5.0A VOLTAGE REGULATOR FOR TTL

The high current 5.0V regulator for TTL shown in *Figure 10* uses a relatively inexpensive NPN pass transistor with a lower power PNP device to replace the single, higher cost, power PNP shown in *Figure 6*. This circuit provides a 5.0V output at up to 5.0A of load current with a typical load regulation of 1.8% from no load to full load. The peak instantaneous output current observed was 10.4A at a 25°C junction temperature (pulsed load with a 1.0 ms ON and a 200 ms OFF period) and 8.4A for a continuous short circuit. The typical line regulation is 0.02% of input voltage change ($I_{OUT} = 0$).

One can easily add an overload indicator using the National's new NSL5027 LED. This is shown with dotted lines in *Figure 10*. With this configuration R2 is not only a current sharing resistor but also an overload sensor. R5 will determine the current through the LED; the diode D2 has been added to match the drop across D1. Once the load current exceeds 5.0A (1.0A through the LM340 assuming perfect current sharing and $V_{D1} = V_{D2}$) Q3 turns ON and the overload indicator lights up.



TL/H/7413-10

FIGURE 10. 5.0V, 5.0A Regulator for TTL (with short circuit, thermal shutdown protection, and overload indicator)

Example:

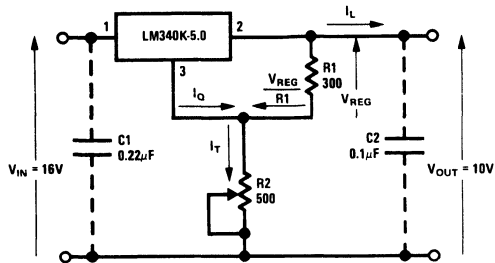
$$I_{OVERLOAD} = 5.0A$$

$$I_{LED} = 40 \text{ mA (light intensity of 16 mcd)}$$

$$V_{LED} = 1.75, R5 \approx \frac{V_{IN} - 2.65}{I_{LED}} \quad (4-1)$$

5. ADJUSTABLE OUTPUT VOLTAGE REGULATOR FOR INTERMEDIATE OUTPUT VOLTAGES

The addition of two resistors to an LM340 circuit allows a non-standard output voltage while maintaining the limiting features built into IC. The example shown in *Figure 11* provides a 10V output using an LM340K-5.0 by raising the reference (pin number 3) of the regulator by 5.0V.



TL/H/7413-11

FIGURE 11. 10V Regulator

The 5.0V pedestal results from the sum of regulator quiescent current I_Q and a current equal to $V_{REG}/R1$, flowing through potentiometer R2 to ground. R2 is made adjustable to compensate for differences in I_Q and V_{REG} output. The circuit is practical because the change in I_Q due to line voltage and load current changes is quite small.

The line regulation for the boosted regulator is the sum of the LM340 line regulation, its effects on the current through

R2, and the effects of ΔI_Q in response to input voltage changes. The change in output voltage is:

$$\Delta V_{OUT} = (L_r/V) \Delta V_{IN} + \frac{(L_r/V) \Delta V_{IN} R2}{R1} + (Q_{CC}/V) \Delta V_{IN} R2 \quad (5-1)$$

giving a total line regulation of:

$$\frac{\Delta V_{OUT}}{\Delta V_{IN}} = (L_r/V) \left(1 + \frac{R2}{R1} \right) + (Q_{CC}/V) R2 \quad (5-2)$$

The LM340-5.0 data sheet lists $\Delta V_{OUT} < 50$ mV and $\Delta I_Q < 1.0$ mA for $\Delta V_{IN} = 18$ V at $I_{OUT} = 500$ mA. This is:

$$L_r/V = \frac{50 \text{ mV}}{18 \text{ V}} \approx 3 \text{ mV/V} \quad (5-3)$$

$$Q_{CC}/V = \frac{1.0 \text{ mA}}{18 \text{ V}} = 55 \text{ } \mu\text{A/V} \quad (5-4)$$

The worst case at line regulation for the circuit of *Figure 11* calculated by equation 5-2, $I_{OUT} = 500$ mA and $R2 = 310 \Omega$ is:

$$\frac{\Delta V_{OUT}}{1.0 \text{ V}} = 3 \text{ mV/V} \left(1 + \frac{310 \Omega}{300 \Omega} \right) + (55 \text{ } \mu\text{A/V}) 310 \Omega \quad (5-5)$$

$$\frac{\Delta V_{OUT}}{1.0 \text{ V}} = 6 \text{ mV/V} + 17 \text{ mV/V} = 23 \text{ mV/V} \quad (5-6)$$

This represents a worst case line regulation value of 0.23%/V.

The load regulation is the sum of the LM340 voltage regulation, its effect on the current through R2, and the effect of ΔI_Q in response to changes in load current. Using the following definitions and the notation shown on *Figure 11* ΔV_{OUT} is:

Z_{OUT} = Regulator output impedance: the change in output voltage per amp of load current change.

Z_{340} = LM340 output impedance

Q_{CC}/A = Quiescent current change per amp of load current change

$$\Delta V_{OUT} = (Z_{340}) \Delta I_L + \frac{(Z_{340})}{R1} \Delta I_L R2 + (Q_{CC}/A) \Delta I_L R2 \quad (5-7)$$

and the total output impedance is:

$$Z_{OUT} = \frac{\Delta V_{OUT}}{\Delta I_L} = Z_{340} \left(1 + \frac{R2}{R1} \right) + (Q_{CC}/A) R2 \quad (5-8)$$

The LM340-5.0 data sheet gives a maximum load regulation $L_r = 50$ mV and $\Delta I_Q = 1.0$ mA for a 1.0A load change.

$$Z_{340} = \frac{50 \text{ mV}}{1.0 \text{ A}} = 0.05 \Omega \quad (5-9)$$

$$Q_{CC}/A = \frac{1 \text{ mA}}{1.0 \text{ A}} = 100 \text{ } \mu\text{A/A} \quad (5-10)$$

This gives a worst case dc output impedance (ac output impedance being a function of C2) for the 10V regulator using equation 5-8 of:

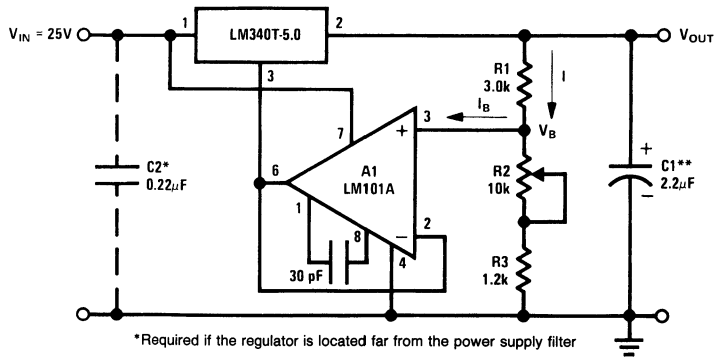
$$Z_{OUT} = 0.05 \Omega \left(1 + \frac{310 \Omega}{300 \Omega} \right) + (100 \text{ } \mu\text{A/A}) 310 \Omega \quad (5-11)$$

$$Z_{OUT} = 0.10 \Omega + 0.031 \Omega = 0.13 \Omega$$

or a worst case change of approximately 1.5% for a 1.0A load change. Typical measured values are about one-third of the worst case value.

6. VARIABLE OUTPUT REGULATOR

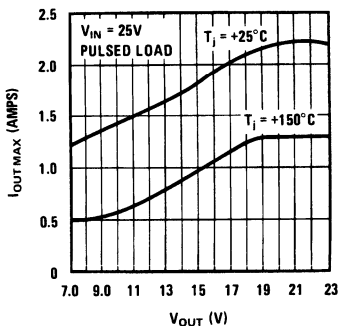
In *Figure 12* the ground terminal of the regulator is "lifted" by an amount equal to the voltage applied to the non-inverting input of the operational amplifier LM101A. The output



*Required if the regulator is located far from the power supply filter
 **Solid tantalum

FIGURE 12. Variable Output Regulator

voltage of the regulator is therefore raised to a level set by the value of the resistive divider R1, R2, R3 and limited by the input voltage. With the resistor values shown in Figure 12, the output voltage is variable from 7.0V to 23V and the maximum output current (pulsed load) varies from 1.2A to 2.0A ($T_j = 25^\circ\text{C}$) as shown in Figure 13.



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FIGURE 13. Maximum Output Current

Since the LM101A is operated with a single supply (the negative supply pin is grounded). The common mode voltage V_B must be at least at a $2.0 V_{BE} + V_{SAT}$ above ground. R_3 has been added to insure this when $R_2 = 0$. Furthermore the bias current I_B of the operational amplifier should be negligible compared to the current flowing through the resistive divider.

Example:

$$V_{IN} = 25V$$

$$V_{OUT\ MIN} = 5 + V_B, (R_2 = 0),$$

$$V_B = R_3 (I - I_B) = 2.0V$$

$$R_1 = 2.5 R_3$$

$$V_{OUT\ MAX} = V_{IN} - \text{dropout volt.}$$

$$(R_2 = R_{2\ MAX})$$

$$R_{2\ MAX} = 3.3 R_1$$

So setting R_3 , the values of R_1 and R_2 can be determined.

If the LM324 is used instead of the LM101A, R_3 can be omitted since its common mode voltage range includes the ground, and then the output will be adjustable from 5 to a certain upper value defined by the parameters of the system.

The circuit exhibits the short-circuit protection and thermal shutdown properties of the LM340 over the full output range.

The load regulation can be predicted as:

$$\Delta V_{OUT} = \frac{R_1 + R_2 + R_3}{R_1} \Delta V_{340} \quad (6-1)$$

where ΔV_{340} is the load regulation of the device given in the data sheet. To insure that the regulator will start up under full load a reverse biased small signal germanium diode, 1N91, can be added between pins 2 and 3.

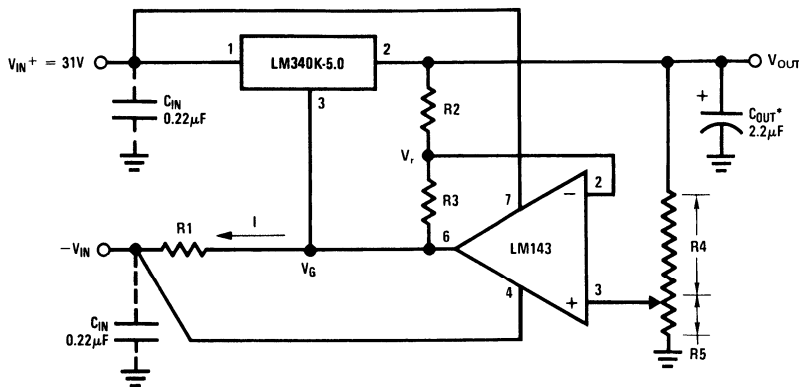
7. VARIABLE OUTPUT REGULATOR 0.5V-29V

When a negative supply is available an approach equivalent to that outlined in section 6 may be used to lower the minimum output voltage of the regulator below the nominal voltage that of the LM340 regulator device. In Figure 14 the voltage V_G at the ground pin of the regulator is determined by the drop across R_1 and the gain of the amplifier. The current I may be determined by the following relation:

$$I = \frac{V_{340}}{R_1} \frac{R_2 R_5 - R_3 R_4}{R_4 (R_2 + R_3)} + \frac{V_{IN-}}{R_1} \quad (7-1)$$

or if $R_2 + R_3 = R_4 + R_5 = R$

$$I = \frac{V_{340}}{R_1} \frac{R_2}{R_4} + \frac{1}{R_1} (V_{IN-} - V_{340}) \quad (7-2)$$



*Solid tantalum

FIGURE 14. Variable Output Voltage 0.5V-30V

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considering that the output is given by:

$$V_{OUT} = V_G + V_{340} \quad (7-3)$$

and

$$V_G = R_1 I - V_{IN}^- \quad (7-4)$$

combining 7-2, 7-3, 7-4 an expression for the output voltage is:

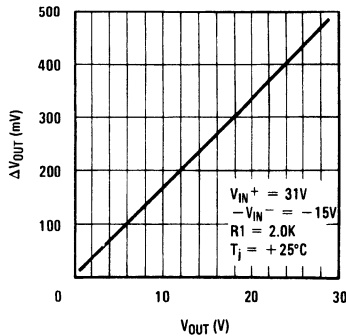
$$V_{OUT} = V_{340} \frac{R_2}{R_4} \quad (7-5)$$

Notice that the output voltage is inversely proportional to R_4 so the output voltage may be adjusted very accurately for low values. A minimum output of 0.5V has been set. This implies that

$$\frac{R_2}{R_4} = 0.1 \frac{R_3}{R_4} = 0.9 \frac{R_3}{R_2} = 9 \quad (7-6)$$

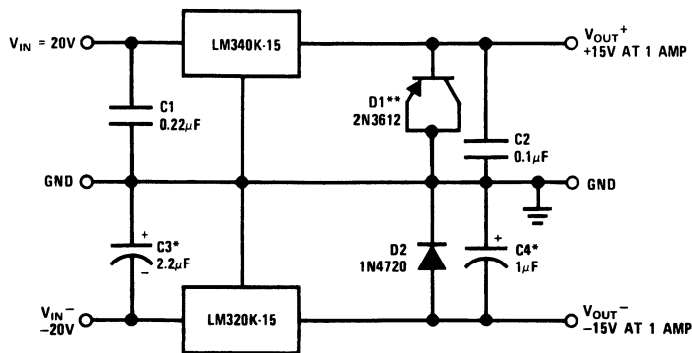
An absolute zero output voltage will require $R_4 = \infty$ or $R_2 = 0$, neither being practical in this circuit. The maximum output voltage as shown in *Figure 14* is 30V if the high voltage operational amplifier LM143 is used. If only low values of V_{OUT} are sought, then an LM101 may be used. R_1 can be computed from:

$$R_1 = \frac{V_{IN}^-}{I_{Q340}} \quad (7-7)$$



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FIGURE 15. Typical Load Regulation for a 0.5V-30V Regulator ($\Delta I_{OUT} = 1.0A$)



*Solid tantalum

**Germanium diode (using a PNP germanium transistor with the collector shorted to the emitter)

Note: C1 and C2 required if regulators are located far from power supply filter.

FIGURE 16. Dual Power Supply

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Figure 15 illustrates the load regulation as a function of the output voltage.

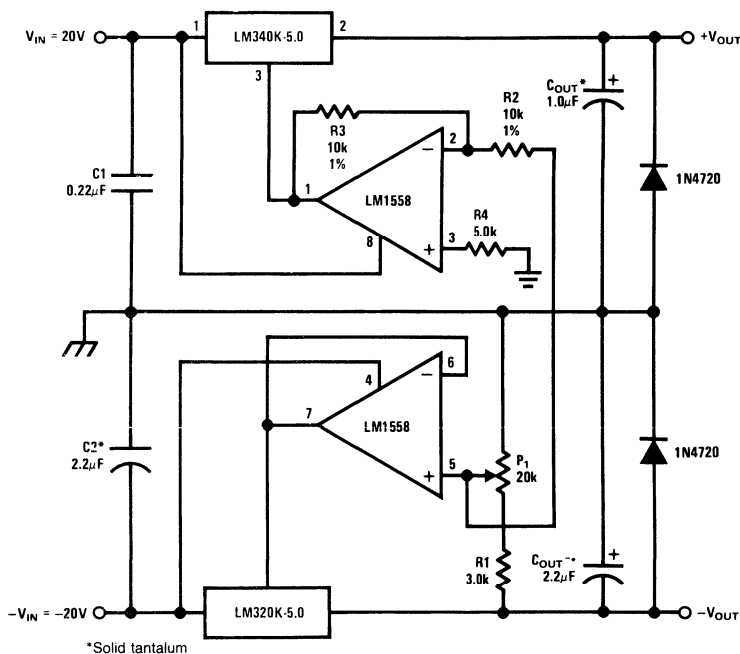
8. DUAL POWER SUPPLY

The plus and minus regulators shown in *Figure 16* will exhibit line and load regulations consistent with their specifications as individual regulators. In fact, operation will be entirely normal until the problem of common loads occurs. A 30Ω load from the +15V output to the -15V output (representing a 0.5A current sink load for the LM340K-15 if the LM320K-15 is already started) would allow start up of the LM340 in most cases. To insure LM340 startup over the full temperature range into a worst case 1.0A current sink load the germanium power "diode" D1 has been added to the circuit. Since the forward voltage drop of the germanium diode D1 is less than that of the silicon substrate diode of the LM340 the external diode will take any fault current and allow the LM340 to start up even into a negative voltage load. D1 and silicon diode D2 also protect the regulator outputs from inadvertent shorts between outputs and to ground. For shorts between outputs the voltage difference between either input and the opposite regulator output should not exceed the maximum rating of the device.

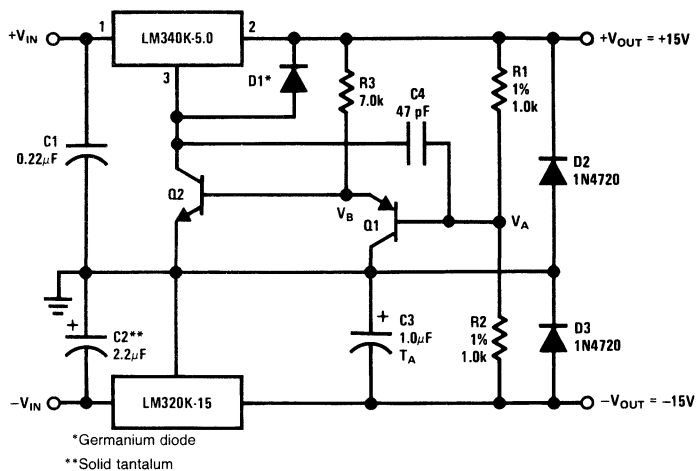
The example shown in *Figure 16* is a symmetrical $\pm 15V$ supply for linear circuits. The same principle applies to non-symmetrical supplies such as a +5.0V and -12V regulator for applications such as registers.

9. TRACKING DUAL REGULATORS

In *Figure 17*, a fraction of the negative output voltage "lifts" the ground pins of the negative LM320K-15 voltage regulator and the LM340K-15 through a voltage follower and an inverter respectively. The dual operational amplifier LM1558 is used for this application and since its supply voltage may go as high as $\pm 22V$ the regulator outputs may be set between 5.0V and 20V. Because of the tighter output tolerance and the better drift of the LM320, the positive regulator is made to track the negative. The best tracking action is achieved by matching the gain of both operational amplifiers, that is, the resistors R_2 and R_3 must be matched as closely as possible.

FIGURE 17. Tracking Dual Supply $\pm 5.0V - \pm 18V$

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FIGURE 18. Tracking Dual Supply $\pm 15V$

TL/H/7413-18

Indeed, with R2 and R3 matched to better than 1%, the LM340 tracks the LM320 within 40–50 mV over the entire output range. The typical load regulation at $V_{OUT} = \pm 15V$ for the positive regulator is 40 mV from a 0 to 1.0A pulsed load and 80 mV for the negative.

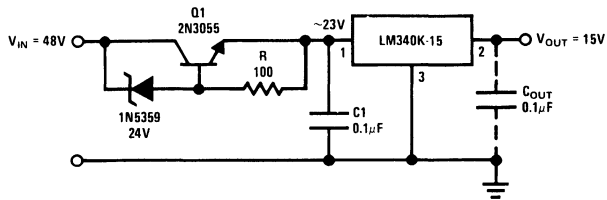
Figure 18 illustrates $\pm 15V$ tracking regulator, where again the positive regulator tracks the negative. Under steady state conditions V_A is at a virtual ground and V_B at a V_{BE} above ground. Q2 then conducts the quiescent current of the LM340. If $-V_{OUT}$ becomes more negative the collector base junction of Q1 is forward biased thus lowering V_B and raising the collector voltage of Q2. As a result $+V_{OUT}$ rises and the voltage V_A again reaches ground potential.

Assuming Q1 and Q2 to be perfectly matched, the tracking action remains unchanged over the full operating temperature range.

With R1 and R2 matched to 1%, the positive regulator tracks the negative within 100 mV (less than 1%). The capacitor C4 has been added to improve stability. Typical load regulations for the positive and negative sides from a 0 to 1.0A pulsed load ($t_{ON} = 1.0$ ms, $t_{OFF} = 200$ ms) are 10 mV and 45 mV respectively.

10. HIGH INPUT VOLTAGE

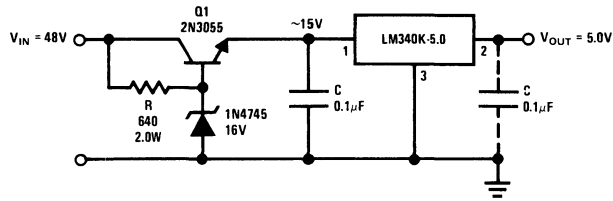
The input voltage of the LM340 must be kept within the limits specified in the data sheet. If the device is operated



*Heat sink Q1 and LM340

FIGURE 19. High Input Voltage

TL/H/7413-19



*Heat sink Q1 and LM340

FIGURE 20. High Input Voltage

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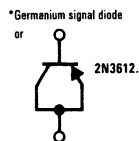
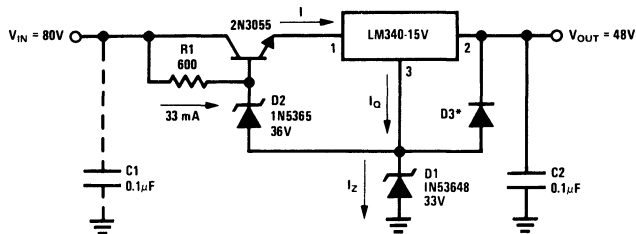


FIGURE 21. High Voltage Regulator

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above the absolute maximum input voltage rating, two failure modes may occur. With the output shorted to ground, the series pass transistor Q16 (see Figure 4) will go to avalanche breakdown; or, even with the output not grounded, the transistor Q1 may fail since it is operated with a collector-emitter voltage approximately 4.0V below the input.

If the only available supply runs at a voltage higher than the maximum specified, one of the simplest ways to protect the regulator is to connect a zener diode in series with the input of the device to level shift the input voltage. The drawback to this approach is obvious. The zener must dissipate ($V_{SUPPLY} - V_{IN\ MAX\ LM340}$) ($I_{OUT\ MAX}$) which may be several watts. Another way to overcome the over voltage problem is illustrated in Figure 19 where an inexpensive, NPN-zener-resistor, combination may be considered as an equivalent to the power zener. The typical load regulation of this circuit is 40 mV from 0 to 1.0A pulsed load ($T_j = 25^\circ\text{C}$) and the line regulation is 2.0 mV for 1.0V variation in the input voltage ($I_{OUT} = 0$). A similar alternate approach is shown in Figure 20.

With an optional output capacitor the measured noise of the circuit was 700 $\mu\text{Vp-p}$.

11. HIGH VOLTAGE REGULATOR

In previous sections the principle of "lifting the ground terminal" of the LM340, using a resistor divider or an operational amplifier, has been illustrated. One can also raise the output voltage by using a zener diode connected to the ground pin as illustrated in the Figure 21 to obtain an output level increased by the breakdown voltage of the zener. Since the input voltage of the regulator has been allowed to go as high as 80V a level shifting transistor-zener (D2)—resistor combination has been added to keep the voltage across the LM340 under permissible values. The disadvantage of the system is the increased output noise and output voltage drift due to the added diodes.

Indeed it can be seen that, from no load to full load conditions, the ΔI_Z will be approximately the current through R1 ($\cong 35\ \text{mA}$) and therefore the degraded regulation caused by D1 will be V_Z (at $35\ \text{mA} + I_Q$) - V_Z (at I_Q).

The measured load regulation was 60 mV for ΔI_{OUT} of 5.0 mA to 1.0A (pulsed load), and the line regulation is 0.01%V of input voltage change ($I_{OUT} = 500$ mA) and the typical output noise 2.0 mVp-p ($C2 = 0.1 \mu\text{F}$). The value of R1 is calculated as:

$$R1 \cong \beta \left[\frac{V_{IN} - (V_{Z1} + V_{Z2})}{I_{\text{full load}}} \right] \quad (11-1)$$

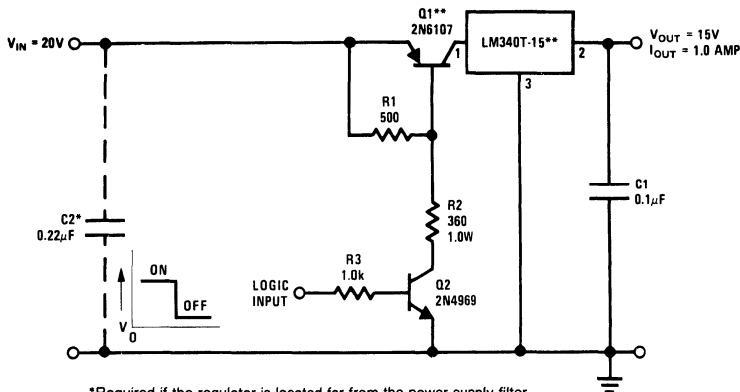
12. ELECTRONIC SHUTDOWN

Figure 22 shows a practical method of shutting down the LM340 under the control of a TTL or DTL logic gate. The pass transistor Q1 operates either as a saturated transistor or as an open switch. With the logic input high (2.4V specified minimum for TTL logic) transistor Q2 turns on and pulls 50 mA down through R2. This provides sufficient base drive

to maintain Q1 in saturation during the ON condition of the switch. When the logic input is low (0.4V specified maximum for TTL logic) Q2 is held off, as is Q1; and the switch is in the OFF condition. The observed turn-on time was 7.0 μs for resistive loads from 15 Ω to infinity and the turn-off time varied from approximately 3.0 μs for a 15 Ω load to 3.0 ms for a no-load condition. Turn-off time is controlled primarily by the time constant of R_{LOAD} and C1.

13. VARIABLE HIGH VOLTAGE REGULATOR WITH OVERVOLTAGE SHUTDOWN

A high voltage variable-output regulator may be constructed using the LM340 after the idea illustrated in section 7 and drawn in Figure 23. The principal inconvenience is that the voltage across the regulator must be limited to maximum

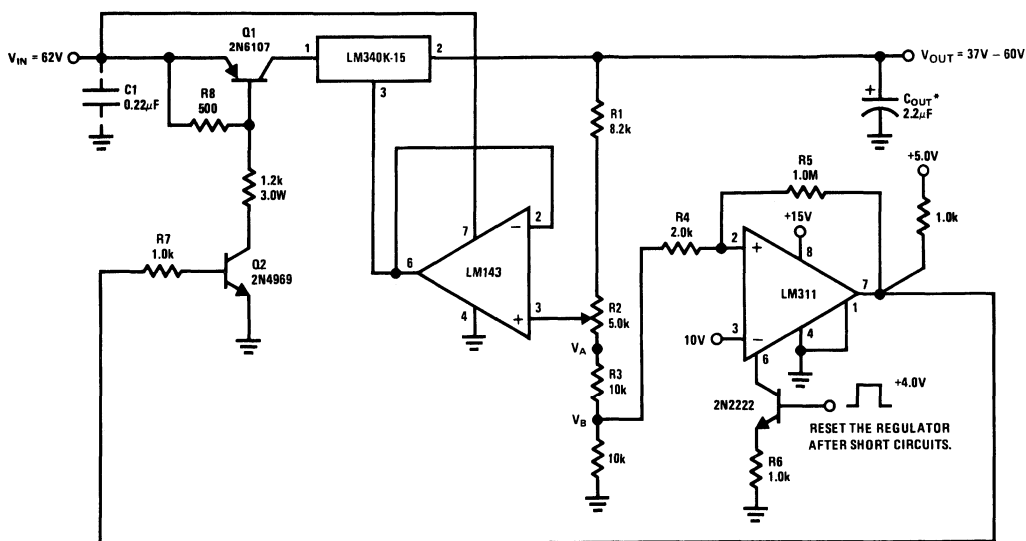


*Required if the regulator is located far from the power supply filter

**Head sink Q1 and the LM340

TL/H/7413-22

FIGURE 22. Electronic Shutdown Circuit



*Solid tantalum

FIGURE 23. Variable High Voltage Regulator with Shortcircuit and Overvoltage Protection

TL/H/7413-23

rating of the device, the higher the applied input voltage the higher must be lifted the ground pin of the LM340. Therefore the range of the variable output is limited by the supply voltage limit of the operational amplifier and the maximum voltage allowed across the regulator. An estimation of this range is given by:

$$V_{OUT\ MAX} - V_{OUT\ MIN} = V_{SUPPLY\ MAX340} - V_{NOMINAL340} - 2.0V \quad (13-1)$$

Examples:

$$LM340-15: V_{OUT\ MAX} - V_{OUT\ MIN} = 35 - 15 - 2 = 18V$$

Figure 23 illustrates the above considerations. Even though the LM340 is by itself short circuit protected, when the output drops, also V_A drops and the voltage difference across the device increases. If it exceeds 35V the pass transistor internal to the regulator will breakdown, as explained in section 11. To remedy this, an over-voltage shutdown is includ-

ed in the circuit. When the output drops the comparator switches low, pulls down the base Q2 thus opening the switch Q1, and shutting down the LM340. Once the short circuit has been removed the LM311 must be activated through the strobe to switch high and close Q1, which will start the regulator again. The additional voltages required to operate the comparator may be taken from the 62V since the LM311 has a certain ripple rejection and the reference voltage (pin 3) may have a superimposed small ac signal. The typical load regulation can be computed from equation 6-1.

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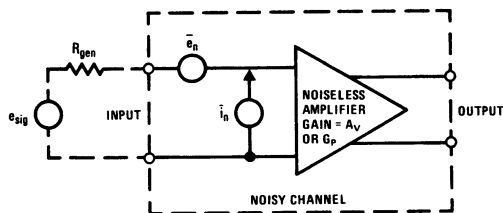
Noise Specs Confusing?



It's really all very simple—once you understand it. Then, here's the inside story on noise for those of us who haven't been designing low noise amplifiers for ten years.

You hear all sorts of terms like signal-to-noise ratio, noise figure, noise factor, noise voltage, noise current, noise power, noise spectral density, noise per root Hertz, broadband noise, spot noise, shot noise, flicker noise, excess noise, 1/F noise, fluctuation noise, thermal noise, white noise, pink noise, popcorn noise, bipolar spike noise, low noise, no noise, and loud noise. No wonder not everyone understands noise specifications.

In a case like noise, it is probably best to sort it all out from the beginning. So, in the beginning, there was noise; and then there was signal. The whole idea is to have the noise very small compared to the signal; or, conversely, we desire a high signal-to-noise ratio S/N. Now it happens that S/N is related to noise figure NF, noise factor F, noise power, noise voltage \bar{e}_n , and noise current \bar{i}_n . To simplify matters, it also happens that any noisy channel or amplifier can be completely specified for noise in terms of two noise generators \bar{e}_n and \bar{i}_n as shown in *Figure 1*.



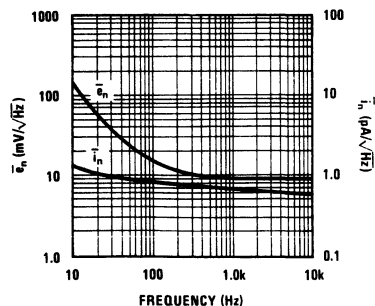
TL/H/7414-1

FIGURE 1. Noise Characterization of Amplifier

All we really need to understand are NF, \bar{e}_n , and \bar{i}_n . So here is a rundown on these three.

NOISE VOLTAGE, \bar{e}_n , or more properly, EQUIVALENT SHORT-CIRCUIT INPUT RMS NOISE VOLTAGE is simply that noise voltage which would appear to originate at the input of the noiseless amplifier if the input terminals were shorted. It is expressed in nanovolts per root Hertz nV/\sqrt{Hz} at a specified frequency, or in microvolts in a given frequency band. It is determined or measured by shorting the input terminals, measuring the output rms noise, dividing by amplifier gain, and referencing to the input. Hence the term, equivalent noise voltage. An output bandpass filter of known characteristic is used in measurements, and the measured value is divided by the square root of the bandwidth \sqrt{B} if data is to be expressed per unit bandwidth or per root Hertz. The level of \bar{e}_n is not constant over the frequency band; typically it increases at lower frequencies as shown in *Figure 2*. This increase is $1/f$ NOISE.

NOISE CURRENT, \bar{i}_n , or more properly, EQUIVALENT OPEN-CIRCUIT RMS NOISE CURRENT is that noise which



TL/H/7414-2

FIGURE 2. Noise Voltage and Current for an Op Amp

occurs apparently at the input of the noiseless amplifier due only to noise currents. It is expressed in picoamps per root Hertz pA/\sqrt{Hz} at a specified frequency or in nanoamps in a given frequency band. It is measured by shunting a capacitor or resistor across the input terminals such that the noise current will give rise to an additional noise voltage which is $\bar{i}_n \times R_{in}$ (or X_{cin}). The output is measured, divided by amplifier gain, referenced to input, and that contribution known to be due to \bar{e}_n and resistor noise is appropriately subtracted from the total measured noise. If a capacitor is used at the input, there is only \bar{e}_n and $\bar{i}_n \times X_{cin}$. The \bar{i}_n is measured with a bandpass filter and converted to pA/\sqrt{Hz} if appropriate; typically it increases at lower frequencies for op amps and bipolar transistors, but increases at higher frequencies for field-effect transistors.

NOISE FIGURE, NF is the logarithm of the ratio of input signal-to-noise and output signal-to-noise.

$$NF = 10 \text{ Log } \frac{(S/N)_{in}}{(S/N)_{out}} \quad (1)$$

where: S and N are power or (voltage)² levels

This is measured by determining the S/N at the input with no amplifier present, and then dividing by the measured S/N at the output with signal source present.

The values of R_{gen} and any X_{gen} as well as frequency must be known to properly express NF in meaningful terms. This is because the amplifier $\bar{i}_n \times Z_{gen}$ as well as R_{gen} itself produces input noise. The signal source in *Figure 1* contains some noise. However e_{sig} is generally considered to be noise free and input noise is present as the THERMAL NOISE of the resistive component of the signal generator impedance R_{gen} . This thermal noise is WHITE in nature as it contains constant NOISE POWER DENSITY per unit bandwidth. It is easily seen from Equation 2 that the \bar{e}_n^2 has the units V^2/Hz and that (\bar{e}_n) has the units V/\sqrt{Hz}

$$\bar{e}_n^2 = 4kTRB \quad (2)$$

where: T is the temperature in °K

R is resistor value in Ω

B is bandwidth in Hz

k is Boltzman's constant

RELATION BETWEEN \bar{e}_n , \bar{i}_n , NF

Now we can examine the relationship between \bar{e}_n and \bar{i}_n at the amplifier input. When the signal source is connected, the \bar{e}_n appears in series with the e_{sig} and e_R . The \bar{i}_n flows through R_{gen} thus producing another noise voltage of value $\bar{i}_n \times R_{gen}$. This noise voltage is clearly dependent upon the value of R_{gen} . All of these noise voltages add at the input in rms fashion; that is, as the square root of the sum of the squares. Thus, neglecting possible correlation between e_n and \bar{i}_n , the total input noise is

$$e_N^2 = e_n^2 + e_R^2 + \bar{i}_n^2 R_{gen}^2 \quad (3)$$

Further examination of the NF equation shows the relationship of \bar{e}_n , \bar{i}_n , and NF.

$$NF = 10 \log \frac{S_{in} \times N_{out}}{S_{out} \times N_{in}}$$

$$= 10 \log \frac{S_{in} G_p \bar{e}_N^2}{S_{in} G_p e_R^2}$$

where: G_p = power gain

$$= 10 \log \frac{\bar{e}_N^2}{e_R^2}$$

$$= 10 \log \frac{\bar{e}_n^2 + e_R^2 + \bar{i}_n^2 R_{gen}^2}{e_R^2}$$

$$NF = 10 \log \left(1 + \frac{\bar{e}_n^2 + \bar{i}_n^2 R_{gen}^2}{e_R^2} \right) \quad (4)$$

Thus, for small R_{gen} , noise voltage dominates; and for large R_{gen} , noise current becomes important. A clear advantage accrues to FET input amplifiers, especially at high values of R_{gen} , as the FET has essentially zero \bar{i}_n . Note, that for an NF value to have meaning, it must be accompanied by a value for R_{gen} as well as frequency.

CALCULATING TOTAL NOISE, \bar{e}_N

We can generate a plot of \bar{e}_N for various values of R_{gen} if noise voltage and current are known vs frequency. Such a graph is shown in Figure 3 drawn from Figure 2. To make this plot, the thermal noise e_R of the input resistance must be calculated from Equation 2 or taken from the graph of Figure 4. Remember that each term in Equation 3 must be squared prior to addition, so the data from Figure 4 and from Figure 2 is squared. A sample of this calculation follows:

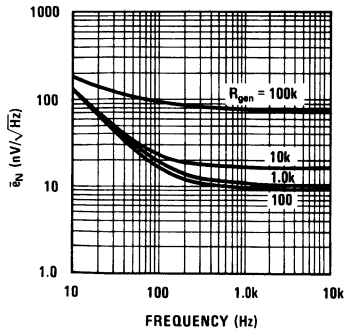
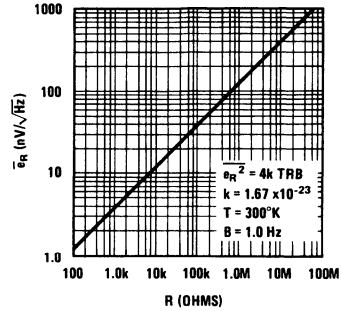


FIGURE 3. Total Noise for the Op Amp of Figure 2

TL/H/7414-3



TL/H/7414-4

FIGURE 4. Thermal Noise of Resistor

Example 1: Determine total equivalent input noise per unit bandwidth for an amplifier operating at 1 kHz from a source resistance of 10 kΩ. Use the data from Figures 2 and 4.

1. Read e_R from Figure 4 at 10 kΩ; the value is 12 nV/√Hz.
2. Read \bar{e}_n from Figure 2 at 1 kHz; the value is 9.5 nV/√Hz.
3. Read \bar{i}_n from Figure 2 at 1 kHz; the value is 0.68 pA/√Hz. Multiply by 10 kΩ to obtain 6.8 nV/√Hz.
4. Square each term individually, and enter into Equation 3.

$$\bar{e}_N = \sqrt{e_n^2 + e_R^2 + \bar{i}_n^2 R_{gen}^2}$$

$$= \sqrt{9.5^2 + 12^2 + 6.8^2} = \sqrt{279}$$

$$\bar{e}_N = 16.7 \text{ nV}/\sqrt{\text{Hz}}$$

This is total rms noise at the input in one Hertz bandwidth at 1 kHz. If total noise in a given bandwidth is desired, one must integrate the noise over a bandwidth as specified. This is most easily done in a noise measurement set-up, but may be approximated as follows:

1. If the frequency range of interest is in the flat band; i.e., between 1 kHz and 10 kHz in Figure 2, it is simply a matter of multiplying \bar{e}_N by the square root of the bandwidth. Then, in the 1 kHz–10 kHz band, total noise is
2. If the frequency band of interest is not in the flat band of Figure 2, one must break the band into sections, calculating average noise in each section, squaring, multiplying by section bandwidth, summing all sections, and finally taking square root of the sum as follows:

$$\bar{e}_N = \sqrt{e_R^2 B + \sum_1^i (e_n^2 + \bar{i}_n^2 R_{gen}^2)_i B_i} \quad (5)$$

where: i is the total number of sub-blocks.

For most purposes a sub-block may be one or two octaves. Example 2 details such a calculation.

Example 2: Determine the rms noise level in the frequency band 50 Hz to 10 kHz for the amplifier of Figure 2 operating from $R_{gen} = 2k$.

1. Read e_R from Figure 4 at 2k, square the value, and multiply by the entire bandwidth. Easiest way is to construct a table as shown on the next page.
2. Read the median value of \bar{e}_n in a relatively small frequency band, say 50 Hz–100 Hz, from Figure 2, square it and enter into the table.

3. Read the median value of \bar{i}_n in the 50 Hz–100 Hz band from *Figure 2*, multiply by $R_{gen} = 2k$, square the result and enter in the table.
4. Sum the squared results from steps 2 and 3, multiply the sum by $\Delta f = 100-50 = 50$ Hz, and enter in the table.
5. Repeat steps 2–4 for band sections of 100 Hz–300 Hz, 300 Hz–1000 Hz and 1 kHz–10 kHz. Enter results in the table.
6. Sum all entries in the last column, and finally take the square root of this sum for the total rms noise in the 50 Hz–10,000 Hz band.
7. Total \bar{e}_n is 1.62 μV in the 50 Hz–10,000 Hz band.

CALCULATING S/N and NF

Signal-to-noise ratio can be easily calculated from known signal levels once total rms noise in the band is determined. Example 3 shows this rather simple calculation from Equation 6 for the data of Example 2.

$$S/N = 20 \log \frac{e_{sig}}{e_N} \tag{6}$$

Example 3: Determine S/N for an rms $e_{sig} = 4$ mV at the input to the amplifier operated in Example 2.

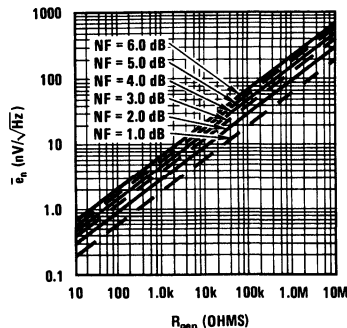
1. RMS signal is $e_{sig} = 4$ mV
2. RMS noise from Example 2 is 1.62 μV
3. Calculate S/N from Equation 6

$$\begin{aligned} S/N &= 20 \log \frac{4 \text{ mV}}{1.62 \mu V} \\ &= 20 \log (2.47 \times 10^3) \\ &= 20 (\log 10^3 + \log 2.47) \\ &= 20 (3 + 0.393) \end{aligned}$$

$$S/N = 68 \text{ dB}$$

It is also possible to plot NF vs frequency at various R_{gen} for any given plot of \bar{e}_n and \bar{i}_n . However there is no specific all-purpose conversion plot relating NF, \bar{e}_n , \bar{i}_n , R_{gen} and f . If either \bar{e}_n or \bar{i}_n is neglected, a reference chart can be constructed. *Figure 5* is such a plot when only \bar{e}_n is considered. It is useful for most op amps when R_{gen} is less than about 200 Ω and for FETs at any R_{gen} (because there is no significant \bar{i}_n for FETs), however actual NF for op amps with $R_{gen} > 200\Omega$ is higher than indicated on the chart. The graph of *Figure 5* can be used to find spot NF if \bar{e}_n and R_{gen} are known, or to find \bar{e}_n if NF and R_{gen} are known. It can also be used to find max R_{gen} allowed for a given max NF when \bar{e}_n is known. In any case, values are only valid if \bar{i}_n

is negligible and at the specific frequency of interest for NF and \bar{e}_n , and for 1 Hz bandwidth. If bandwidth increases, the plot is valid so long as \bar{e}_n is multiplied by \sqrt{B} .



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FIGURE 5. Spot NF vs R_{gen} when Considering *Only* \bar{e}_n and \bar{e}_R (not valid when $\bar{i}_n R_{gen}$ is significant)

THE NOISE FIGURE MYTH

Noise figure is easy to calculate because the signal level need not be specified (note that e_{sig} drops out of Equation 4). Because NF is so easy to handle in calculations, many designers tend to lose sight of the fact that signal-to-noise ratio $(S/N)_{out}$ is what is important in the final analysis, be it an audio, video, or digital data system. One can, in fact, choose a high R_{gen} to reduce NF to near zero if \bar{i}_n is very small. In this case \bar{e}_R is the major source of noise, overshadowing \bar{e}_n completely. The result is very low NF, but very low S/N as well because of very high noise. Don't be fooled into believing that low NF means low noise *per se!*

Another term is worth considering, that is optimum source resistance R_{OPT} . This is a value of R_{gen} which produces the lowest NF in a given system. It is calculated as

$$R_{OPT} = \frac{\bar{e}_n}{\bar{i}_n} \tag{7}$$

This has been arrived at by differentiating Equation 4 with respect to R_{gen} and equating it to zero (see Appendix). *Note that this does not mean lowest noise.*

For example, using *Figure 2* to calculate R_{OPT} at say 600 Hz,

$$R_{OPT} = \frac{10 \text{ nV}}{0.7 \text{ pA}} = 14 \text{ k}\Omega$$

TABLE I. Noise Calculations for Example 2

B (Hz)	Δf (Hz)	\bar{e}_n^2 (nV/Hz)	$+\bar{i}_n^2 R_{gen}^2$	=	SUM x Δf	=	(nV ²)
50–100	50	$(20)^2 = 400$	$(8.7 \times 2.0k)^2$	=	302	702×50	35,000
100–300	200	$(13)^2 = 169$	$(8 \times 2.0k)^2$	=	256	425×200	85,000
300–1000	700	$(10)^2 = 100$	$(7 \times 2.0k)^2$	=	196	296×700	207,000
1.0k–10k	9000	$(9)^2 = 81$	$(6 \times 2.0k)^2$	=	144	225×9000	2,020,000
50–10,000	9950	$\bar{e}_R^2 = (5.3)^2 = 28$				28×9950	279,000
Total $\bar{e}_N = \sqrt{2,626,000} = 1620 \text{ nV} = 1.62 \mu V$							

*The units are as follows: $(20 \text{ nV}/\sqrt{\text{Hz}})^2 = 400 \text{ (nV}^2/\text{Hz)}$
 $(8.7 \text{ pA}/\sqrt{\text{Hz}} \times 2.0 \text{ k}\Omega)^2 = (17.4 \text{ nA}/\sqrt{\text{Hz}})^2 = 302 \text{ (nV}^2/\text{Hz)}$
 Sum = $702 \text{ (nV}^2/\text{Hz)} \times 50 \text{ Hz} = 35,000 \text{ (nV}^2)$

Then note in *Figure 3*, that \bar{e}_N is in the neighborhood of 20 nV/√Hz for R_{gen} of 14k, while $\bar{e}_N = 10$ nV/√Hz for $R_{gen} = 0-100\Omega$. STOP! Do not pass GO. Do not be fooled. Using $R_{gen} = R_{OPT}$ does not guarantee lowest noise UNLESS $e_{sig}^2 = kR_{gen}$ as in the case of transformer coupling. When $e_{sig}^2 > kR_{gen}$, as is the case where signal level is proportional to R_{gen} ($e_{sig} = kR_{gen}$), it makes sense to use the highest practical value of R_{gen} . When $e_{sig}^2 < kR_{gen}$, it makes sense to use a value of $R_{gen} < R_{OPT}$. These conclusions are verified in the Appendix.

This all means that it does not make sense to tamper with the R_{gen} of existing signal sources in an attempt to make $R_{gen} = R_{OPT}$. Especially, do not add series resistance to a source for this purpose. It does make sense to adjust R_{gen} in transformer coupled circuits by manipulating turns ratio or to design R_{gen} of a magnetic pick-up to operate with pre-amps where R_{OPT} is known. It does make sense to increase the design resistance of signal sources to match or exceed R_{OPT} so long as the signal voltage increases with R_{gen} in at least the ratio $e_{sig}^2 \propto R_{gen}$. It does not necessarily make sense to select an amplifier with R_{OPT} to match R_{gen} because one amplifier operating at $R_{gen} = R_{OPT}$ may produce lower S/N than another (quieter) amplifier operating with $R_{gen} \neq R_{OPT}$.

With some amplifiers it is possible to adjust R_{OPT} over a limited range by adjusting the first stage operating current (the National LM121 and LM381 for example). With these, one might increase operating current, varying R_{OPT} , to find a condition of minimum S/N. Increasing input stage current decreases R_{OPT} as \bar{e}_n is decreased and i_n is simultaneously increased.

Let us consider one additional case of a fairly complex nature just as a practical example which will point up some factors often overlooked.

Example 4: Determine the S/N *apparent to the ear* of the amplifier of *Figure 2* operating over 50-12,800 Hz when driven by a phonograph cartridge exhibiting $R_{gen} = 1350\Omega$, $L_{gen} = 0.5H$, and average $e_{sig} = 4.0$ mVrms. The cartridge is to be loaded by 47k as in *Figure 6*. This is equivalent to using a Shure V15, Type 3 for average level recorded music.

1. Choose sectional bandwidths of 1 octave each, these are listed in the following table.
2. Read \bar{e}_n from *Figure 2* as average for each octave and enter in the table.
3. Read i_n from *Figure 2* as average for each octave and enter in the table.
4. Read \bar{e}_R for the $R_{gen} = 1350\Omega$ from *Figure 4* and enter in the table.
5. Determine the values of Z_{gen} at the midpoint of each octave and enter in the table.
6. Determine the amount of \bar{e}_R which reaches the amplifier input; this is

$$\bar{e}_R \frac{R1}{R1 + Z_{gen}}$$

7. Read the noise contribution \bar{e}_{47k} of $R1 = 47k$ from *Figure 4*.
8. Determine the amount of \bar{e}_{47k} which reaches the amplifier input; this is

$$\bar{e}_{47k} \frac{Z_{gen}}{R1 + Z_{gen}}$$

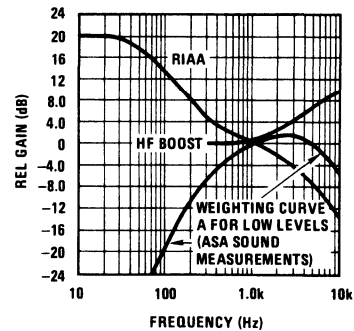


FIGURE 7. Relative Gain for RIAA, ASA Weighting A, and H-F Boost Curves

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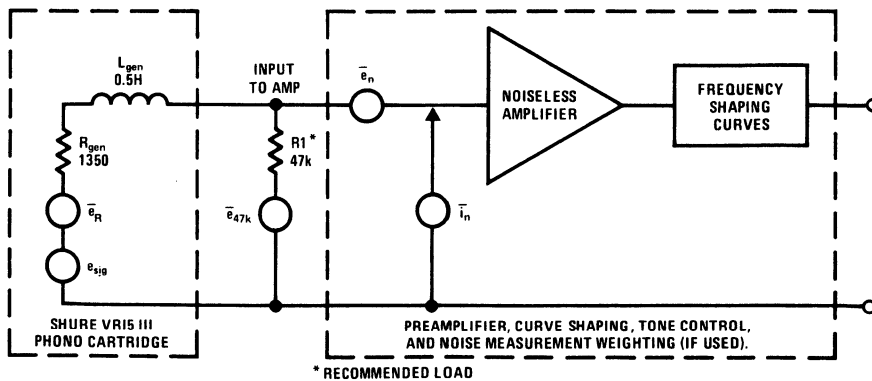


FIGURE 6. Phono Preamp Noise Sources

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9. Determine the effective noise contributed by i_n flowing through the parallel combination of $R1$ and Z_{gen} . This is
$$i_n \frac{Z_{gen} R1}{Z_{gen} + R1}$$
10. Square all noise voltage values resulting from steps 2, 6, 8 and 9; and sum the squares.
11. Determine the relative gain at the midpoint of each octave from the RIAA playback response curve of *Figure 7*.
12. Determine the relative gain at these same midpoints from the A weighted response curve of *Figure 7* for sound level meters (this roughly accounts for variations in human hearing).
13. Assume a tone control high frequency boost of 10 dB at 10 kHz from *Figure 7*. Again determine relative response of octave midpoints.
14. Multiply all relative gain values of steps 11-13 and square the result.
15. Multiply the sum of the squared values from step 10 by the resultant relative gain of step 14 and by the bandwidth in each octave.
16. Sum all the values resultant from step 15, and find the square root of the sum. This is the total audible rms noise apparent in the band.
17. Divide $e_{sig} = 4$ mV by the total noise to find S/N = 6.95 dB.

STEPS FOR EXAMPLE

1	Frequency Band (Hz)	50-100	100-200	200-400	400-800	800-1600	1.6-3.2k	3.2-6.4k	6.4-12.8k	
	Bandwidth, B (Hz)	50	100	200	400	800	1600	3200	6400	
	Bandcenter, f (Hz)	75	150	300	600	1200	2400	4800	9600	
5	Z_{gen} at f (Ω)	1355	1425	1665	2400	4220	8100	16k	32k	
	$Z_{gen} R1$ (Ω)	1300	1360	1600	2270	3900	6900	11.9k	19k	
	$Z_{gen}/R1 + Z_{gen}$	0.028	0.030	0.034	0.485	0.082	0.145	0.255	0.400	
	$R1/(R1 + Z_{gen})$	0.97	0.97	0.97	0.95	0.92	0.86	0.74	0.60	
11	RIAA Gain, A_{RIAA}	5.6	3.1	2.0	1.4	1	0.7	0.45	0.316	
12	Corr for Hearing, A_A	0.08	0.18	0.45	0.80	1	1.26	1	0.5	
13	H-F Boost, A_{boost}	1	1	1	1	1.12	1.46	2.3	3.1	
14	Product of Gains, A	0.45	0.55	0.9	1.12	1.12	1.28	1.03	0.49	
	A^2	0.204	0.304	0.81	1.26	1.26	1.65	1.06	0.241	
4	\bar{e}_R (nV/ \sqrt{Hz})	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5	
7	\bar{e}_{47k} (nV/ \sqrt{Hz})	29	29	29	29	29	29	29	29	
3	\bar{i}_n (pA/ \sqrt{Hz})	0.85	0.80	0.77	0.72	0.65	0.62	0.60	0.60	
2	\bar{e}_n (nV/ \sqrt{Hz})	19	14	11	10	9.5	9	9	9	
9	$\bar{e}_1 = \bar{i}_n (Z_{gen} R1)$	1.1	1.09	1.23	1.63	2.55	4.3	7.1	11.4	
6	$\bar{e}_2 = \bar{e}_R R1/(R1 + Z_{gen})$	4.35	4.35	4.35	4.25	4.15	3.86	3.33	2.7	
8	$\bar{e}_3 = \bar{e}_{47k} Z_{gen}/(R1 + Z_{gen})$	0.81	0.87	0.98	1.4	2.4	4.2	7.4	11.6	
10	\bar{e}_n^2	360	195	121	100	90	81	81	81	
	\bar{e}_1^2 (from \bar{i}_n)	1.21	1.2	1.5	2.65	6.5	18.5	50	150	
	\bar{e}_2^2 (from \bar{e}_R)	19	19	19	18	17	15	11	7.2	
	\bar{e}_3^2 (from \bar{e}_{47k})	0.65	0.76	0.96	2	5.8	18	55	135	
	$\Sigma \bar{e}_n^2$ (nV ² /Hz)	381	216	142	122	120	133	147	373	
15	BA^2 (Hz)	10.2	30.4	162	504	1010	2640	3400	1550	
	$BA^2 \Sigma \bar{e}_n^2$ (nV ²)	3880	6550	23000	61500	121000	350000	670000	580000	
16	$\Sigma (\bar{e}_n^2 + \bar{e}_1^2 + \bar{e}_2^2 + \bar{e}_3^2) B_i A_i^2 = 1,815,930$ nV ²									
	$\bar{e}_N = \sqrt{\Sigma} = 1.35$ μ V									
17	S/N = 20 log (4.0 mV/1.35 μ V) = 69.5 dB									

Note the significant contributions of \bar{i}_n and the 47k resistor, especially at high frequencies. Note also that there will be a difference between calculated noise and that noise measured on broadband meters because of the A curve employed in the example. If it were not for the A curve attenuation at low frequencies, the \bar{e}_n would add a very important contribution below 200 Hz. This would be due to the RIAA boost at low frequency. As it stands, 97% of the 1.35 μV would occur in the 800–12.8 kHz band alone, principally because of the high frequency boost and the A measurement curve. If the measurement were made without either the high frequency boost or the A curve, the \bar{e}_n would be 1.25 μV . In this case, 76% of the total noise would arise in the 50 Hz–400 Hz band alone. If the A curve were used, but the high-frequency boost were deleted, \bar{e}_n would be 0.91 μV ; and 94% would arise in the 800–12, 800 Hz band alone.

The three different methods of measuring would only produce a difference of +3.5 dB in overall S/N, however the prime sources of the largest part of the noise and the frequency character of the noise can vary greatly with the test or measurement conditions. It is, then, quite important to know the method of measurement in order to know which individual noise sources in *Figure 6* must be reduced in order to significantly improve S/N.

APPENDIX I

Derivation of R_{OPT} :

$$NF = 10 \log \frac{\bar{e}_R^2 + \bar{e}_n^2 + \bar{i}_n^2 R_{gen}^2}{\bar{e}_R^2}$$

$$10 \log \left(1 + \frac{\bar{e}_n^2 + \bar{i}_n^2 R_{gen}^2}{\bar{e}_R^2} \right)$$

$$\frac{\delta NF}{\delta R} = \frac{0.435}{(4 \text{ kTRB})^2} \frac{4 \text{ kTRB} (2R \bar{i}_n^2) - (\bar{e}_n^2 + \bar{i}_n^2 R^2) 4 \text{ kTB}}{1 + (\bar{e}_n^2 + \bar{i}_n^2 R^2)/4 \text{ kTRB}}$$

where: $R = R_{gen}$

Set this = 0, and

$$4 \text{ kTRB}(2R \bar{i}_n^2) = 4 \text{ kTB} (\bar{e}_n^2 + \bar{i}_n^2 R^2)$$

$$2 \bar{i}_n^2 R^2 = \bar{e}_n^2 + \bar{i}_n^2 R^2$$

$$\bar{i}_n^2 R^2 = \bar{e}_n^2$$

$$R^2 = \bar{e}_n^2 / \bar{i}_n^2$$

$$R_{OPT} = \frac{\bar{e}_n}{\bar{i}_n}$$

APPENDIX II

Selecting R_{gen} for highest S/N.

$$S/N = \frac{e_{sig}^2}{B(\bar{e}_R^2 + \bar{e}_n^2 + \bar{i}_n^2 R^2)}$$

For S/N to increase with R,

$$\frac{\delta S/N}{\delta R} > 0$$

$$\frac{\delta S/N}{\delta R} = \frac{2e_{sig} (\delta e_{sig} / \delta R) (\bar{e}_R^2 + \bar{e}_n^2 + \bar{i}_n^2 R^2) - e_{sig}^2 (4 \text{ kT} + 2 \bar{i}_n^2 R)}{B(\bar{e}_R^2 + \bar{e}_n^2 + \bar{i}_n^2 R^2)^2}$$

CONCLUSIONS

The main points in selecting low noise preamplifiers are:

1. Don't pad the signal source; live with the existing R_{gen} .
2. Select on the basis of low values of \bar{e}_n and especially \bar{i}_n if R_{gen} is over about a thousand Ω .
3. Don't select on the basis of NF or R_{OPT} in most cases. NF specs are all right so long as you know precisely how to use them and so long as they are valid over the frequency band for the R_{gen} or Z_{gen} with which you must work.
4. Be sure to (root) sum all the noise sources \bar{e}_n , \bar{i}_n and \bar{e}_R in your system over appropriate bandwidth.
5. The higher frequencies are often the most important unless there is low frequency boost or high frequency attenuation in the system.
6. Don't forget the filtering effect of the human ear in audio systems. Know the eventual frequency emphasis or filtering to be employed.

APPENDIX II (Continued)

If we set > 0 , then

$$2 (\delta e_{\text{sig}} / \delta R) (\overline{e_{R^2}} + \overline{e_{n^2}} + \overline{i_{n^2}} R^2) > e_{\text{sig}} (4 kT + 2 \overline{i_{n^2}} R)$$

$$\text{For } e_{\text{sig}} = k_1 \sqrt{R}, \delta e_{\text{sig}} / \delta R = \frac{k_1}{2\sqrt{R}}$$

$$(2 k_1 / 2\sqrt{R}) (\overline{e_{R^2}} + \overline{e_{n^2}} + \overline{i_{n^2}} R^2) > k_1 \sqrt{R} (4 kT + 2 \overline{i_{n^2}} R)$$

$$\overline{e_{R^2}} + \overline{e_{n^2}} + \overline{i_{n^2}} R^2 > 4 kTR + 2 \overline{i_{n^2}} R^2$$

$$\overline{e_{n^2}} > \overline{i_{n^2}} R^2$$

$$R < \overline{e_n} / \overline{i_n}$$

Therefore S/N increases with R_{gen} so long as $R_{\text{gen}} \leq R_{\text{OPT}}$

$$\text{For } e_{\text{sig}} = k_1 R, \delta e_{\text{sig}} / \delta R = k_1$$

$$2 k_1 (\overline{e_{R^2}} + \overline{e_{n^2}} + \overline{i_{n^2}} R^2) > k_1 R (4 kT + 2 \overline{i_{n^2}} R)$$

$$\frac{2 \overline{e_{R^2}} + 2 \overline{e_{n^2}} + 2 \overline{i_{n^2}} R^2 > 4 kTR + 2 \overline{i_{n^2}} R^2}{\overline{e_{R^2}} + 2 \overline{e_{n^2}} > 0}$$

Then S/N increases with R_{gen} for any amplifier.

For any $e_{\text{sig}} < k_1 \sqrt{R}$, an optimum R_{gen} may be determined. Take, for example, $e_{\text{sig}} = k_1 R^{0.4}$, $\delta e_{\text{sig}} / \delta R = 0.4 k_1 R^{-0.6}$

$$(0.8 k_1 / R^{0.6}) (\overline{e_{R^2}} + \overline{e_{n^2}} + \overline{i_{n^2}} R^2) > k_1 R^{0.4} (4 kT + 2 \overline{i_{n^2}} R)$$

$$0.8 \overline{e_{R^2}} + 0.8 \overline{e_{n^2}} + 0.8 \overline{i_{n^2}} R^2 > 4 kTR + 2 \overline{i_{n^2}} R^2$$

$$0.8 \overline{e_{n^2}} > 0.2 \overline{e_{R^2}} + 1.2 \overline{i_{n^2}} R^2$$

Then S/N increases with R_{gen} until

$$0.25 \overline{e_{R^2}} + 1.5 \overline{i_{n^2}} R^2 = \overline{e_{n^2}}$$

Fast IC Power Transistor with Thermal Protection

National Semiconductor
Application Note 110



INTRODUCTION

Overload protection is perhaps most necessary in power circuitry. This is shown by recent trends in power transistor technology. Safe-area, voltage and current handling capability have been increased to limits far in excess of package power dissipation. In RF transistors, devices are now available and able to withstand badly mismatched loads without destruction. However, for anyone working with power transistors, they are still easily destroyed.

Since power circuitry, in many cases, drives other low level circuitry—such as a voltage regulator—protection is doubly important. Overloads that cause power transistor failure can result in the destruction of the entire circuit. This is because the common failure mode for power transistors is a short from collector to emitter—applying full voltage to the load. In the case of a voltage regulator, the raw supply voltage would be applied to the low level circuitry.

A new monolithic power transistor provides virtually absolute protection against any type of overload. Included on the chip are current limiting, safe area protection and thermal limiting. Current limiting controls the peak current through the chip to a safe level below the fusing current of the aluminum metalization. At high collector to emitter voltage the safe area limiting reduces the peak current to further protect the power transistor. If, under prolonged overload, power dissipation causes chip temperature to rise toward destructive levels, thermal limiting turns off the device keeping the devices at a safe temperature. The inclusion of thermal limiting, a feature not easily available in discrete circuitry makes this device especially attractive in applications where normal protective schemes are ineffective.

The device's high gain and fast response further reduce requirements of surrounding circuitry. As well as being used in linear applications, the IC can interface transistor-transistor logic or complementary-MOS logic to power loads without external devices. In fact, the input-current requirement of 3 microamperes is small enough for one CMOS gate to drive over 400 LM195's.

Besides high dc current gain, the IC has low input capacitance so it can be easily driven from high impedance sources—even at high frequencies. In a standard TO-3 power package, the monolithic structure ties the emitter, rather than the collector, to the case effectively boot-strapping the base-to-package capacitance. Additionally, connecting the emitter to the package is especially convenient for grounded emitter circuits.

The device is fully protected against any overload condition when it is used below the maximum voltage rating. The current-limiting circuitry restricts the power dissipation to 35 watts, 1.8 amperes are available at collector-to-emitter volt-

age of 17V decreasing to about 0.8 amperes at 40V. In reality, however, like standard transistors, power dissipation in actual use is limited by the size of the external heat sink.

Switching time is fast also. At 40V 25 Ohm load can be switched on or off in a relatively fast 500 ns. The internal planar double diffused monolithic transistors have an f_t of 200 MHz to 400 MHz. The limiting factor on overall speed is the protective and biasing circuitry around the output transistors. An important performance point is that no more than the normal $3 \mu\text{A}$ base current is needed for fast switching.

To the designer, the LM195 acts like an ordinary power transistor, and its operation is almost identical to that of a standard power device. However, it provides almost absolute protection against any type of overload. And, since it is manufactured with standard seven-mask IC technology, the device is producible in large quantities at reasonable cost.

CIRCUIT DESIGN

Besides the protective features, the monolithic power transistor should function as closely to a discrete transistor as possible. Of course, due to the circuitry on the chip, there will be some differences.

Figure 1 shows a simplified schematic of the power transistor. A power NPN Darlington is driven by an input PNP. The PNP and output NPN's are biased by internal current source I_1 . The composite three transistors yield a total current gain in excess of 10^6 making it easy to drive the power transistors from high impedance sources. Unlike normal power transistors, the base current is negative, flowing out of the PNP. However, in most cases this is not a problem.

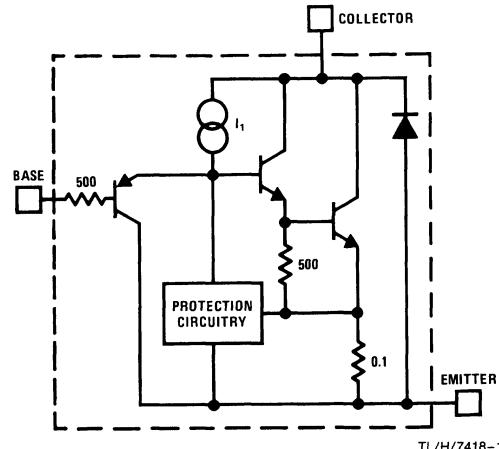


FIGURE 1. Simplified Circuit of the LM195

TL/H/7418-1

The input PNP transistor is made with standard IC processing and has a reverse base-emitter breakdown voltage in excess of 40V. This allows the power transistor to be driven from a stiff voltage source without damage due to excessive base current. At input voltages in excess of about 1V the input PNP becomes reverse biased and no current is drawn from the base lead. In fact it is possible for the base of the monolithic transistor to be driven with up to 40V even though the collector to emitter voltage is low. Further, the input PNP isolates the base drive from the protective circuitry insuring that even with high base drive the device will be protected. When the device is turned off current I_1 is shunted from the base of the NPN transistor by the PNP and appears at the emitter terminal. This sets the minimum load current to about 2 mA, not a severe restriction for a power transistor. Because of the PNP and I_1 , the power transistor turns "on" rather than "off" if the base is opened; however, most power circuits already include a base-emitter resistor to absorb leakage currents in present power transistors.

A schematic of the LM195 is shown in *Figure 2*. The circuitry is biased by four current sources comprised of Q4, Q7, Q8 and Q9. The operating current is set by Q5 and Q6 and is relatively independent of supply voltage. FET Q1 and R2 insure reliable starting of the bias circuitry while D1 clamps the output of the FET limiting the starting current at high supply voltage.

The output transistors Q19 and Q20 are driven from input PNP Q14. Current limiting independent of temperature changes is provided by Q21, Q16, and Q15. At high collector to emitter voltages the current limit decreases due to the voltage across R21 from D3, D4 and R20. The double emitter structure used on Q21 allows the power limiting to more closely approximate constant power curve rather than a

straight line decrease in output current as input voltage increases.

Transistor Q13 thermally limits the device by removing the base drive at high temperature. The actual temperature sensing is done by Q11 and Q12 with Q10 regulating the voltage across the sensors so thermal limit temperature remains independent of supply. As temperature increases, the collector current of Q11 increases while the V_{BE} of Q12 decreases. At about 170°C the Q12 turns on Q13 removing the base drive from the output transistors. Finally, C1, Q2 and Q3 boost operating currents during switching to obtain faster response time and Q17 and Q18 compensate for h_{fe} variations in the power devices.

PERFORMANCE

The new power transistor is packaged in a standard TO-3 transistor package making it compatible with standard power transistors. An added advantage of the monolithic structure is that the emitter is tied to the case rather than the collector. This allows the device to be connected directly to ground in collector output applications.

A photomicrograph of the LM195 is shown in *Figure 3*. More than half of the die area is needed for the output power transistor (Q20). Actually, the power transistor is many individual small transistors connected in parallel with a common collector. Partitioning the power device into small discrete areas improves power handling over a single large device. Firstly, the power device has ten base sections spread across the chip. Between the base diffusion are N+ collector contacts. Each section has its own emitter ballasting resistor to insure current sharing between sections. One of these resistors is used to sense the output current for current limiting.

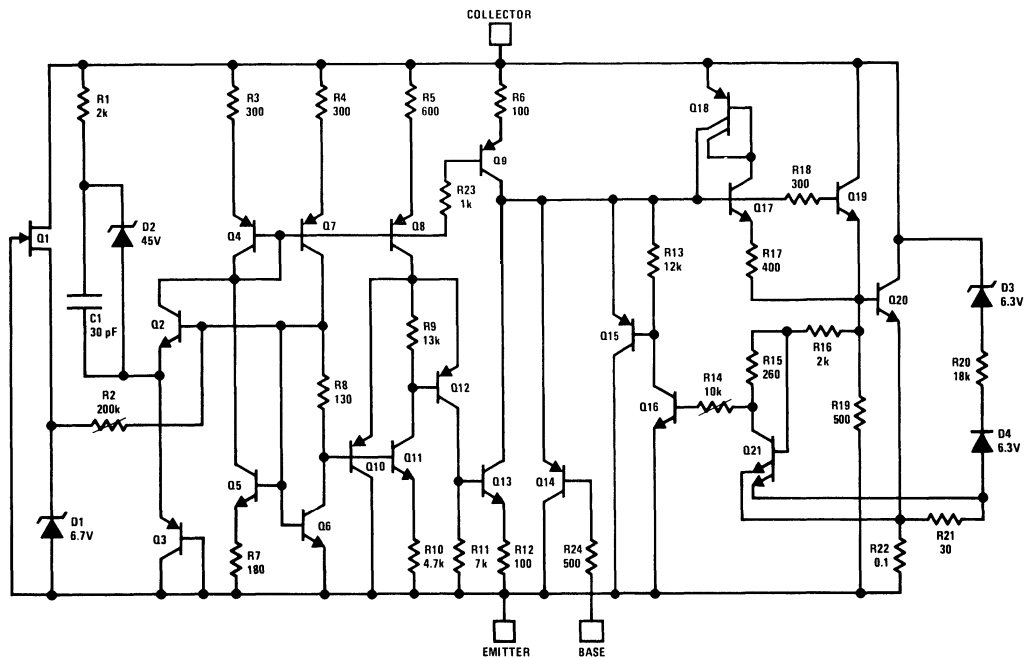
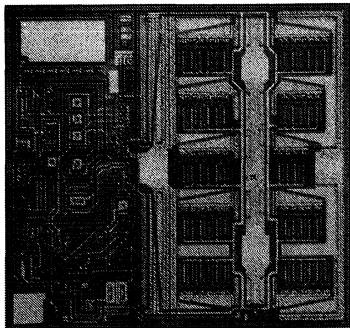


FIGURE 2. Schematic Diagram of the LM195

TL/H/7418-2



TL/H/7418-3

FIGURE 3. LM195 Chip

TABLE I. Typical Performance

Collector to Emitter Voltage	42V
Base to Emitter Voltage (max.)	42V
Peak Collector Current (internally limited)	1.8 amps
Reverse Base Emitter Voltage	20V
Base to Emitter Voltage ($I_C = 1.0$ amp)	0.9V
Base Current	$3 \mu\text{A}$
Saturation Voltage	2V
Switching Time (turn on or turn off)	500 ns
Power Dissipation (internally limited)	35 watts
Thermal Limit Temperature	165°C
Maximum Operating Temperature	150°C
Thermal Resistance (Junction to Case)	2.3°C/W

A detail of one of the base sections is shown in Figure 4. An interdigitated structure is used with alternating base contacts and emitter stripes. Integrated into each emitter is an individual emitter ballasting resistor to insure equal current sharing between emitters in each section. Aluminum metallization runs the length of the emitter stripe to prevent lateral

voltage drop from debiasing a section of the stripe at high operating currents. All current in the stripe flows out through the small ballasting resistor where it is summed with the currents from the other stripes in the section. The partitioning in conjunction with the emitter resistor gives a power transistor with large safe-area and good power handling capability.

APPLICATIONS

With the full protection and high gain offered by this monolithic power transistor, circuit design is considerably simplified. The inclusion of thermal limiting, not normally available in discrete design allows the use of smaller heat sinks than with conventional protection circuitry. Further, circuits where protection of the power device is difficult—if not impossible—now cause no problems.

For example, with only current limiting, the power transistor heat sink must be designed to dissipate worst case overload power dissipation at maximum ambient temperature. When the power transistor is thermally limited, only normal power need be dissipated by the heat sink. During overload, the device is allowed to heat up and thermally limit, drastically reducing the size of the heat sink needed.

Switching circuits such as lamp drivers, solenoid drivers or switching regulators do not dissipate much power during normal operation and usually no heat sink is necessary. However, during overload, the full supply voltage times the maximum output current must be dissipated. Without a large heat sink standard power transistors are quickly destroyed.

Using this new device is easier than standard power transistors but a few precautions should be observed. About the only way the device can be destroyed is excessive collector to emitter voltage or improper power supply polarity. Sometimes when used as an emitter follower, low level high frequency oscillations can occur. These are easily cured inserting a 5k-10k resistor in series with the base lead. The resistor will eliminate the oscillation without effecting speed or performance. Good power supply bypassing should also be used since this is a high frequency device.

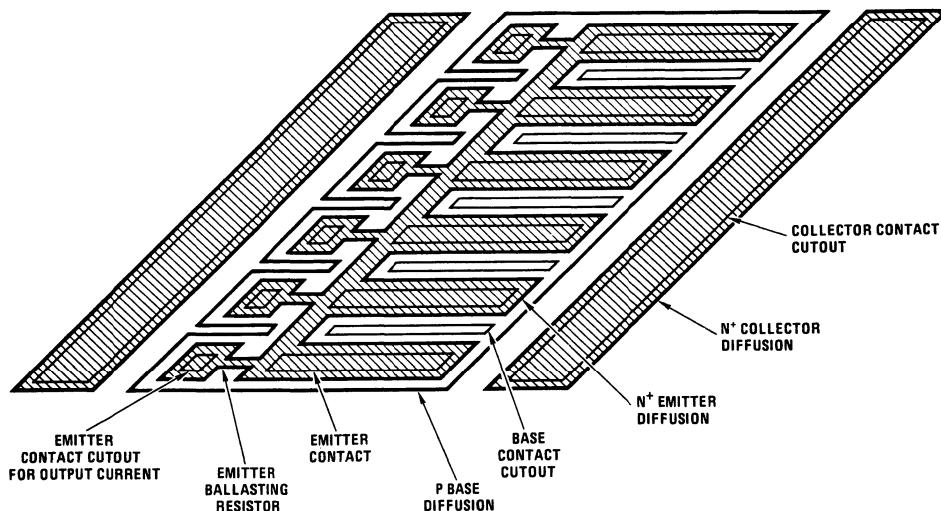
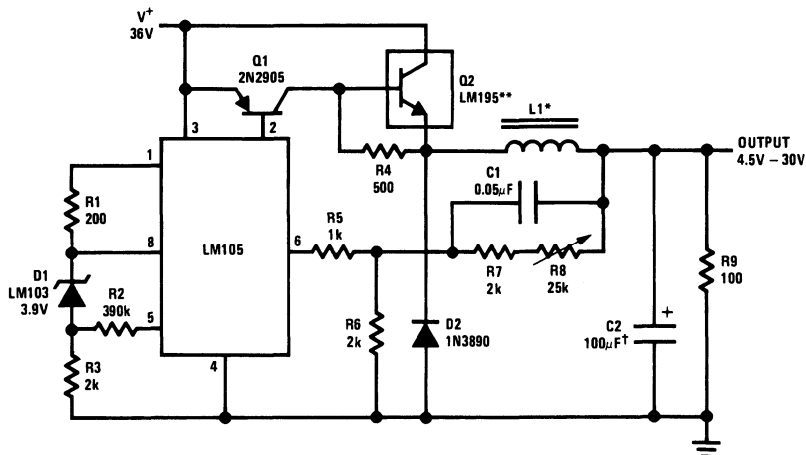


FIGURE 4. Detailed Structure of one Section of the Power Transistor

TL/H/7418-4



*Sixty turns wound on arnold type A-083081-2 core.

**Four devices in parallel.

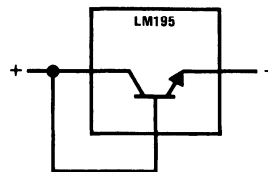
†Solid tantalum.

TL/H/7418-5

FIGURE 5. 6 Amp Variable Output Switching Regulator

Figure 5 shows a 6 amp, variable output switching regulator for general purpose applications. An LM105 positive regulator is used as the amplifier-reference for the switching regulator. Positive feedback to induce switching is obtained from the LM105 at pin 1 through an LM103 diode. The positive feedback is applied to the internal amplifier at pin 5 and is independent of supply voltage. This forces the LM105 to drive the pass devices either "on" or "off," rather than linearly controlling their conduction. Negative feedback, delayed by L1 and the output capacitor, C2, causes the regulator to switch with the duty cycle automatically adjusting to provide a constant output. Four LM195's are used in parallel to obtain a 6 amp output since each device can only supply about 2 amps. Note that no ballasting resistors are needed for current sharing. When Q1 turns "on" all bases are pulled up to V⁺ and no base current flows in the LM195 transistors since the input PNP's are reverse biased.

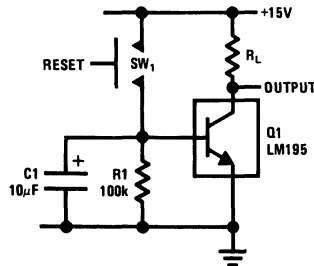
A two terminal current/power limiter is shown in Figure 6. The base and collector are shorted—turning the power transistor on. If the load current exceeds 2 amps, the device current limits protecting the load. If the overload remains on, the device will thermal limit, further protecting itself and the load. In normal operation, only 2V appear across the device so high efficiency is realized and no heat sink is needed. Another method of protection would be to place the monolithic power transistor on a common heat sink with the devices to be protected. Overheating will then cause the LM195 to thermal limit protecting the rest of the circuitry.



TL/H/7418-6

FIGURE 6. Two Terminal Current Limiter

The low base current make this power device suitable for many unique applications. Figure 7 shows a time delay circuit. Upon application of power or S1 closing, the load is energized. Capacitor C1 slowly charges toward V⁻ through R1. When the voltage across R1 decreases below about 0.8 volts the load is de-energized. Long delays can be obtained with small capacitor values since a high resistance can be used.



TL/H/7418-7

FIGURE 7. Time Delay Circuit

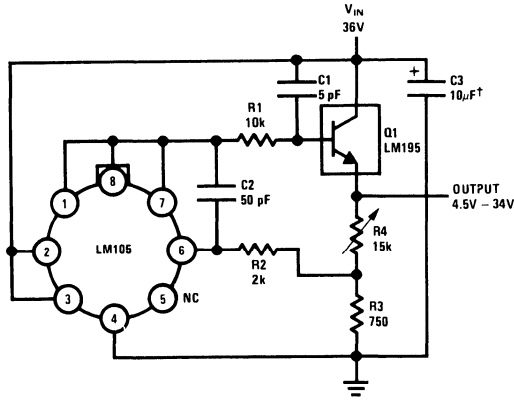
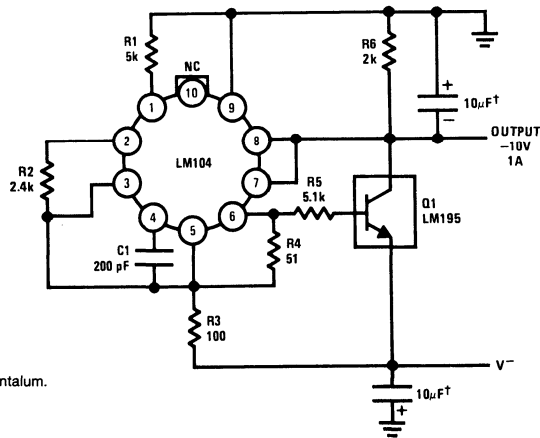


FIGURE 8. 1 Amp Positive Voltage Regulator

TL/H/7418-8



†Solid tantalum.

FIGURE 9. 1 Amp Negative Regulator

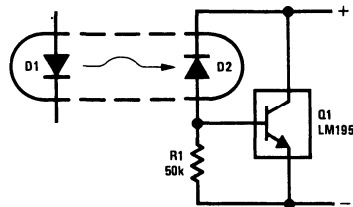
TL/H/7418-9

Figures 8 and 9 show how the LM195 can be used with standard IC's to make positive or negative voltage regulators. Since the current gain of the LM195 is so high, both regulators have better than 2 mV load regulation. They are both fully overload protected and will operate with only 2V input-to-output voltage differential.

An optically isolated power transistor is shown in Figure 10. D1 and D2 are almost any standard optical isolator. With no drive, R1 absorbs the base current of Q1 holding it off. When power is applied to the LED, D2 allows current to flow

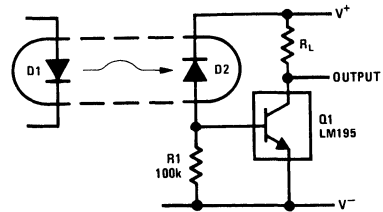
from the collector to base. Less than 20 µA from the diode is needed to turn the LM195 fully on.

An alternate connection for better ac response is to return the cathode of D2 to separate positive supply rather than the collector of Q1, as shown in Figure 11, eliminating the added collector to base capacitance of the diode. With this circuit a 40V 1 amp load can be switched in 500 ns. Of course, any photosensitive diode can be used instead of the opto-isolator to make a light activated switch.



TL/H/7418-10

FIGURE 10. Optically Isolated Power Transistor



TL/H/7418-11

FIGURE 11. Fast Optically Isolated Switch

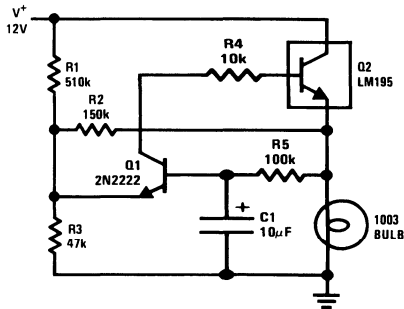
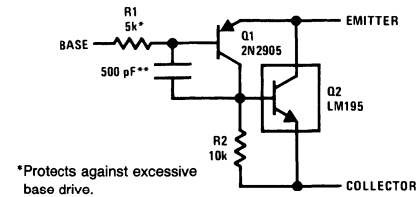


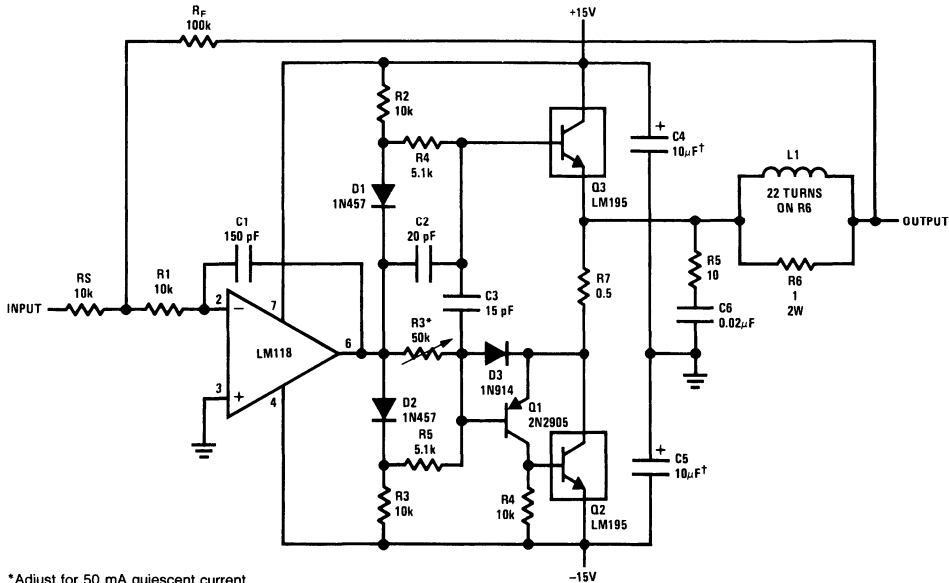
FIGURE 12. 1 Amp Lamp Flasher TL/H/7418-12



*Protects against excessive base drive.
**Needed for stability.

TL/H/7418-13

FIGURE 13. PNP Configuration for LM195



*Adjust for 50 mA quiescent current.
†Solid tantalum.

FIGURE 14. Power Op Amp

TL/H/7418-14

A power lamp flasher is shown in *Figure 12*. It is designed to flash a 12V bulb at about a once-per second rate. The reverse base current of Q2 provides biasing for Q1 eliminating the need for a resistor. Typically, a cold bulb can draw 8 times its normal operating current. Since the LM195 is current limited, high peak currents to the bulb are not experienced during turn-on. This prolongs bulb life as well as easing the load on the power supply.

Since no PNP equivalent of this device is available, it is advantageous to use the LM195 in a quasi-complementary configuration to simulate a power PNP. *Figure 13* shows a quasi PNP made with an LM195. A low current PNP is used to drive the LM195 as the power output device. Resistor R1 protects against overdrive destroying the PNP and, in conjunction with C1, frequency compensates the loop against oscillations. Resistor R2 sets the operating current for the PNP and limits the collector current.

Figure 14 shows a power op amp with a quasi-complementary power output stage. Q1 and Q2 form the equivalent of a power PNP. The circuit is simply an op amp with a power output stage. As shown, the circuit is stable for almost any load. Better bandwidth can be obtained by decreasing C1 to 15 pF (to obtain 150 kHz full output response), but capaci-

tive loads can cause oscillation. If due to layout, the quasi-complementary loop oscillates, collector to base capacitance on Q1 will stabilize it. A simpler power op amp for up to 300 Hz operation is shown in *Figure 15*.

One of the more difficult circuit types to protect is a current regulator. Since the current is already fixed, normal protection doesn't work. Circuits to limit the voltage across the current regulator may allow excessive current to flow through the load. About the only protection method that protects both the regulator and the driven circuit is thermal limiting.

A 100 mA, two terminal regulator is shown in *Figure 16*. The circuit has low temperature coefficient and operates down to 3V. Once again, the reverse base current of the LM195 to bias the operating circuitry.

A 2N2222 is used to control the voltage across a current sensing resistor, R2 and diode D1, and therefore the current through it. The voltage across the sense network is the V_{BE} of the 2N2222 plus 1.2V from the LM113. In the sense network R2 sets the current while D1 compensates for the V_{BE} of the transistor. Resistor R1 sets the current through the LM113 to 0.6 mA.

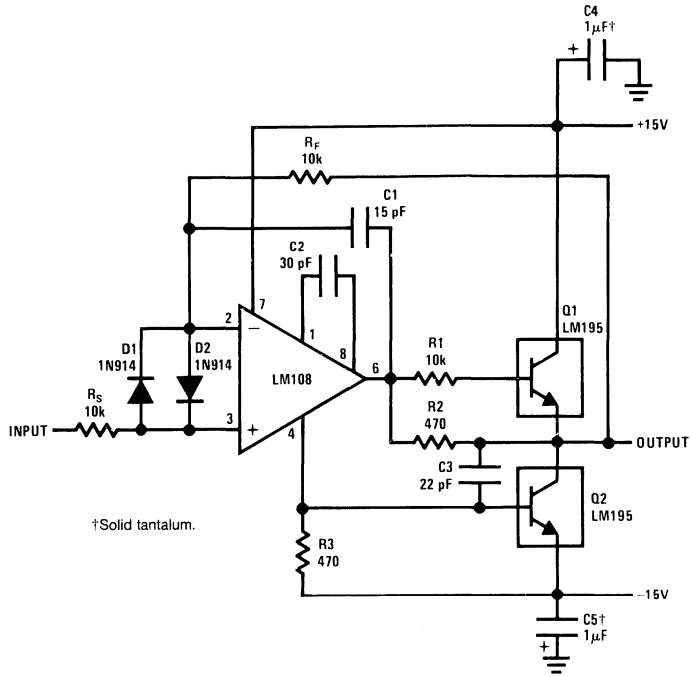


FIGURE 15. 1 Amp Voltage Follower

TL/H/7418-15

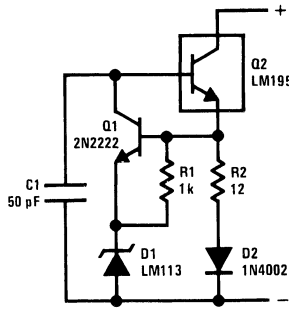


FIGURE 16. Two Terminal 100 mA Current Regulator

TL/H/7418-16

CONCLUSIONS

A new IC power transistor has been developed that significantly improves power circuitry reliability. The device is virtually impossible to destroy through abuse. Further it has high gain and fast response. It is manufactured with standard

seven mask IC technology making it produceable in large quantities at reasonable prices. Finally, in addition to the protection features, it has high gain simplifying surrounding circuitry.

Wide Range Function Generator

National Semiconductor
Application Note 115



AN-115

The sine, square, triangle function generator has proven to be exceptionally useful. Various IC circuits have been published for generating square and triangle waveforms in an attempt to duplicate the general purpose function generator. However, these simple circuits are usually limited to about 10 kHz and have no sine wave output. The function generator shown here provides all three waveforms and operates from below 10 Hz to 1 MHz with usable output to about 2 MHz.

DESIGN

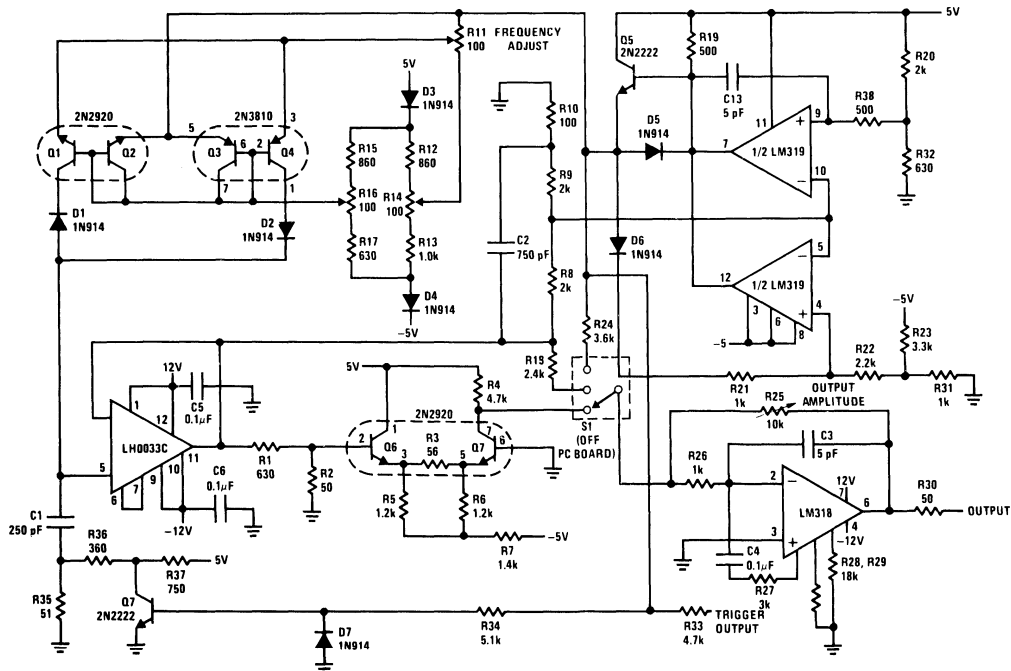
As with most function generators, an integrator-comparator generates the square and triangle waveforms with a shaping circuit forming the triangle wave into a sine wave.

Obtaining six decades of operating with a single control plus 2 MHz operation requires some unusual circuit design tech-

niques as well as good high frequency IC's. The triangle wave is generated by switching current-source transistors to alternately charge and discharge the timing capacitor. This generates a linear tri-wave without the use of an op amp integrator. A FET voltage follower buffers the tri-wave and drives the comparator, output amplifier and sine converter.

A precision dual comparator is used to set the peak-to-peak amplitude of the tri-wave. It is necessary to accurately control the tri-wave since the sine converter requires close amplitude control to produce a low distortion output. An accurate divider across the 5V supply regulators sets the threshold at the inputs of the LM319 comparators. The tri-wave is applied to the other comparator inputs through another divider—R8, R9, R10 and C2. The comparator switches when the amplitude of the tri-wave is $\pm 2.5V$. Capacitor C2 compensates for delays in the comparator at high frequencies.

Function Generator Schematic



TL/H/7423-1

PARTS LIST

R1	630Ω	1%	C1	250 pF	
R2	50Ω	1%	C2	750 pF	
R3	56Ω	5%	C3	5 pF	
R4	4.7k	5%	C4	0.1 μF	
R5	1.2k	1%	C5	0.1 μF	
R6	1.2k	1%	C6	0.1 μF	
R7	1.4K	1%	C7	500 μF	25V
R8	2k	5%	C8	500 μF	25V
R9	2k	5%	C9	4.7 μF	Solid Tantalum
R10	100Ω	5%	C10	4.7 μF	Solid Tantalum
R11	100Ω potentiometer		C11	4.7 μF	Solid Tantalum
R12	860Ω	5%	C12	4.7 μF	Solid Tantalum
R13	1k	5%	C13	5 pF	
R14	100Ω PC mount trimpot				
R15	860Ω	5%			
R16	100Ω PC mount trimpot		Q1-Q2	2N2920	Dual NPN
R17	630Ω	5%	Q3-Q4	2N3810	Dual PNP
R18	2.4k	5%	Q5	2N2222	
R19	500Ω	5%	Q6-Q7	2N2920	Dual NPN
R20	2k	5%	Q8	2N2222	
R21	1k	5%			
R22	2.2k	5%	D1-D7	1N914	
R23	3.3k	5%		1—Varo VE27 Full Wave Bridge	
R24	3.6k	5%			
R25	10k potentiometer			1—LM318H Operational Amplifier	
R26	1k	5%		1—LM319N Dual Comparator	
R27	3k	5%		1—LH0033C Fast Buffer	
R28	18k	5%		1—LM340K	12V Positive Voltage Regulator
R29	18k	5%		1—LM320K	-12V Negative Voltage Regulator
R30	50Ω	5%		1—LM309H	5V Positive Voltage Regulator
R31	1k	5%		1—LM320H	-5V Negative Voltage Regulator
R32	630Ω	5%			
R33	4.7k	5%		T1 = Triad F90X	
R34	5.1k	5%			
R35	51Ω	5%		S ₁ —3 Position ST Switch	
R36	360Ω	5%		S ₂ —SPST Switch	
R37	750Ω	5%			
R38	500Ω	5%		¼ Amp Fuse and Holder—PC Board, Mounting Hardware, etc.	

A square wave output from the comparator is obtained at the emitter of Q5 and is used to drive both the current switches and output amplifier. The current switches—Q1, Q2, Q3, Q4—provide a 5 nA to 5 mA current to timing capacitor, C1. The exponential relationship between emitter-base voltage and collector current allows a six decade current range to be obtained with a single potentiometer. The maximum output current is set by the current through R15 and R17 (depending on polarity) and appears when the arm of the frequency control, R11, ties all four emitters together. As R11 is rotated, a voltage is developed between the emitters of Q1-Q4 and Q2-Q3. This voltage decreases the emitter base voltage of Q1 and Q4 decreasing their operating current. About 380 mV is developed across R11 and corresponds to over a 10^6 reduction in charging current. Converting the tri-wave to a sine wave also uses the non-linear relationship between emitter-base voltage and collector current of a transistor pair.

Transistors Q6 and Q7 form a differential amplifier with emitter degeneration. The tri-wave is attenuated by R1 and R2 to about 450 mV and applied to one half of the pair—Q6. This drives the transistors non-linearly producing a sine wave output current at the collector of Q7 to drive the output amplifier.

The output amp, an LM318, uses feedforward compensation to maximize bandwidth and slew rate. It is used for adjustable scaling of all three waveforms to $\pm 10V$. Even with the feedforward, there is not quite enough bandwidth for good reproduction of the triangle or square wave at frequencies over 1 MHz. Therefore, if the higher frequencies are of major interest, a faster output amplifier is necessary.

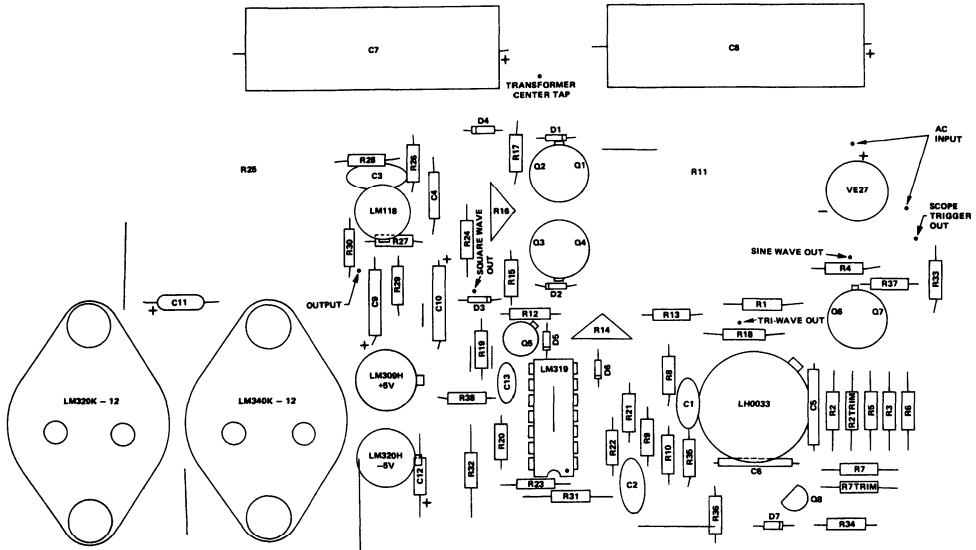
CONSTRUCTION AND SET UP

It is important to observe good construction practices for proper operation. All four power supplies should be bypassed with 4.7 μF solid tantalum capacitors on the circuit board. Since the circuit operates at relatively high frequencies, short leads and a compact layout is a good idea. The wiring to the function selector switch should be made with shielded wire to minimize spikes from the fast square wave. At low frequencies, charging currents to the timing capacitor are quite low, so 60 Hz pickup can modulate the operating frequency. Shielding the current sources and C1 from the power transformer is in order.

All transistors used to set the timing currents must track with temperature changes. Of course, the individual pairs will track but the NPN pair must also track the PNP pair as well. There are many small heat sinks for transistors which can be used to thermally couple Q1, Q2, to Q3, Q4. Temperature differences between the pair will cause the symmetry to change.

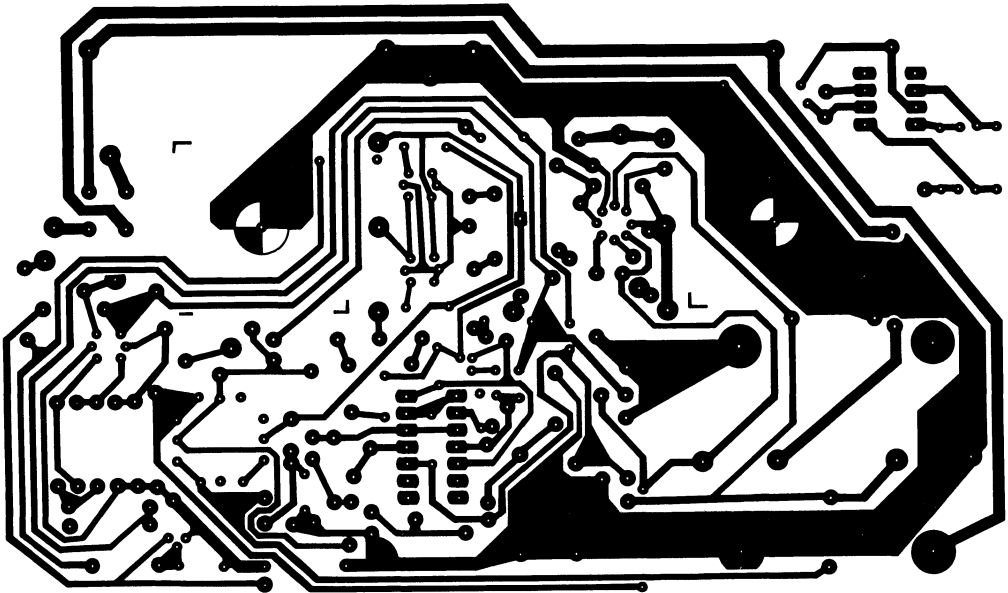
Set up is not difficult either. Firstly, R11 is set for a 1 MHz output. Then R16 is used to adjust the output symmetry. Secondly, R11 is set to provide a 10 Hz output and the symmetry is again adjusted by R14.

Other possible adjustments that may be necessary are in the sine converter. R7 can be trimmed if the sine output (from the LM318) has a dc offset. Also, it may be necessary to adjust R2 to minimize distortion. (It should be mentioned that there can be considerable distortion if the symmetry of the tri-wave is not 50%.)



Component Location, Top View

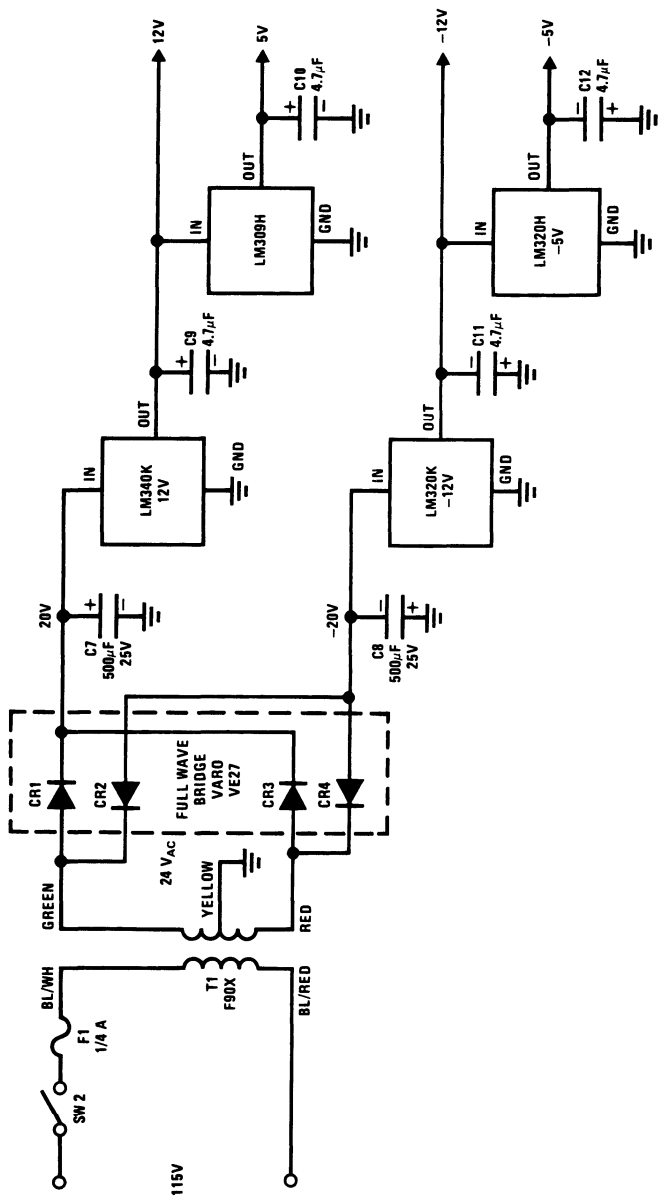
TL/H/7423-2



Circuit Board Layout

(This PC layout must be enlarged approximately 120% in order to be usable.)

TL/H/7423-4



Power Supply Section Schematic

TL/H/7483-3

Use the LM158/LM258/ LM358 Dual, Single Supply Op Amp

National Semiconductor
Application Note 116
Jim Sherwin



INTRODUCTION

Use the LM158/LM258/LM358 dual op amp with a single supply in place of the LM1458/LM1558 with split supply and reap the profits in terms of:

- Input and output voltage range down to the negative (ground) rail
- Single supply operation
- Lower standby power dissipation
- Higher output voltage swing
- Lower input offset current
- Generally similar performance otherwise

The main advantage, of course, is that you can eliminate the negative supply in many applications and still retain equivalent op amp performance. Additionally, and in some cases more importantly, the input and output levels are permitted to swing down to ground (negative rail) potential. Table I shows the relative performance of the two in terms of guaranteed and/or typical specifications.

In many applications the LM158/LM258/LM358 can also be used directly in place of LM1558 for split supply operation.

SINGLE SUPPLY OPERATION

The LM1458/LM1558 or similar op amps exhibit several important limitations when operated from a single positive (or negative) supply. Chief among these is that input and output signal swing is severely limited for a given supply as shown in *Figure 1*. For linear operation, the input voltage must not reach within 3 volts of ground or of the supply, and output range is similarly limited to within 3–5 volts of ground or supply. This means that operation with a +12V supply could be limited as low as 2 Vp-p output swing. The LM358 however, allows a 10.5 Vp-p output swing for the same 12V supply. Admittedly these are worst case specification limits, but they serve to illustrate the problem.

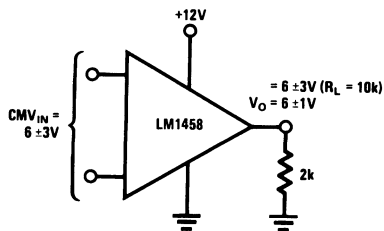
TABLE I. Comparison of Dual Op Amps LM1458 and LM358

Characteristic	LM1458	LM358
V_{IO}	6 mV Max	7 mV Max
CM V_I	24 Vp-p*	0–28.5V*
I_{IO}	200 nA	50 nA
I_{OB}	500 nA	–500 nA
CMRR	60 dB Min @ 100 Hz 90 dB Typ	85 dB Typ @ DC
\bar{e}_n @ 1 kHz, R_{GEN} 10 k Ω	45 nV/ \sqrt{Hz} Typ	40 nV/ \sqrt{Hz} Typ**
Z_{IN}	200 M Ω Typ	Typ 100 M Ω
A_{VOL}	20k Min 100k Typ	100k Typ
f_c	1.1 MHz Typ	1 MHz Typ**
P_{BW}	14 kHz Typ	11 kHz Typ**
dV_o/dt	0.8V/ μs Typ	0.5V/ μs Typ**
V_o @ $R_L = 10k/2k$	24/20 Vp-p*	28.5 Vp-p
I_{SC}	20 mA Typ	Source 20 mA Min (40 Typ) Sink 10 mA Min (20 Typ)
PSRR @ DC	37 dB Min 90 dB Typ	100 dB Typ
I_D ($R_L = \infty$)	8 mA Max	2 mA Max

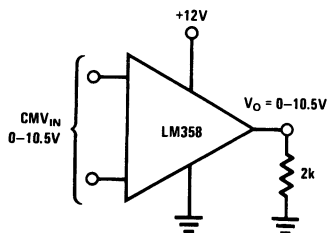
‡From laboratory measurement

*Based on $V_S = 30V$ on LM358 only, or $V_S = \pm 15V$

**From data sheet typical curves

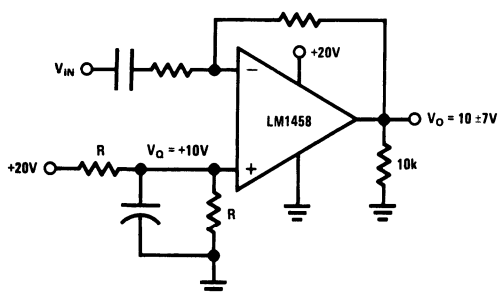


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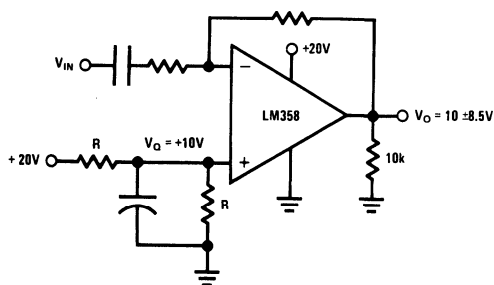


TL/H/7424-2

FIGURE 1. Worst Case Signal Levels with +12V Supply



TL/H/7424-3



TL/H/7424-4

FIGURE 2. Operating with AC Signals

AC GAIN

For AC signals the input can be capacitor coupled. The input common mode and quiescent output voltages are fixed at one-half the supply voltage by a resistive divider at the non-inverting input as shown in *Figure 2*. This quiescent output could be set at a lower voltage to minimize power dissipation in the LM358, if desired, so long as $V_Q \geq V_{IN}$ pk. For the LM1458 the quiescent output must be higher, $V_Q \geq 3V + V_{IN}$ pk thus, for small signals, power dissipation is much greater with the LM1458. Example: Required $V_O = V_Q \pm 1V$ pk into $2k$, $V_{SUPPLY} =$ as required. Find quiescent dissipation in load and amplifier for LM1458 and LM358.

LM358

$$V_Q = +1V$$

$$V_{SUPPLY} = +3.5V$$

$$P_{LOAD} = \frac{E_L^2}{R_L} = \frac{1}{2k} = 0.5 \text{ mW}$$

$$P_D = V_S I_S^* + (V_S - V_Q) I_L$$

$$= 3.5V \times 0.7 \text{ mA} + (3.5 - 1) \frac{1V}{2k}$$

$$P_D = 2.45 + 1.25 = 3.7 \text{ mW}$$

$$P_{TOTAL} = 3.7 + 0.5 = 4.2 \text{ mW}$$

*From typical characteristics

LM1458

$$V_Q = 4V$$

$$V_{SUPPLY} = 8V$$

$$P_{LOAD} = \frac{4^2}{2k} = 8 \text{ mW}$$

$$P_D = P_D^* + (V_S - V_Q) I_L$$

$$= 22 \text{ mW} + (8 - 4) \frac{4V}{2k}$$

$$P_D = 22 + 8 = 30 \text{ mW}$$

$$P_{TOTAL} = 30 + 8 = 38 \text{ mW}$$

*From typical characteristics

The LM1458 requires over twice the supply voltage and nearly 10 times the supply power of the LM358 in this application.

INVERTING DC GAIN

Connections and biasing for DC inverting gain are essentially the same as for the AC coupled case. Note, of course, that the output cannot swing negative when operated from a single positive supply. *Figure 3* shows the connections and signal limitations.

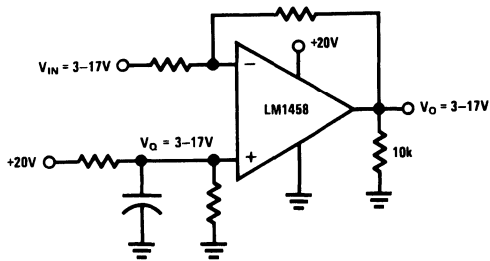
NON-INVERTING DC GAIN

The non-inverting gain connection does not require the V_Q biasing as before; the inverting input can be returned to ground in the usual manner for gains greater than unity, (see *Figure 4*). A tremendous advantage of the LM358 in this connection is that input signals and output may extend all the way to ground; therefore DC signals in the low-millivolt range can be handled. The LM1458 still requires that $V_{IN} = 3-17V$. Therefore maximum gain is limited to $A_V = (V_O - 3)/3$, or $A_V \text{ max} = 5.4$ for a 20V supply.

There is no similar limitation for the LM358.

ZERO T.C. INPUT BIAS CURRENT

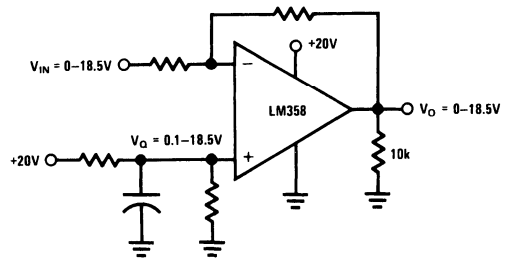
An interesting and unusual characteristic is that I_{IN} has a zero temperature coefficient. This means that matched resistance is not required at the input, allowing omission of one resistor per op amp from the circuit in most cases.



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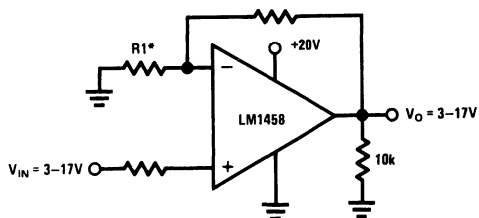
BALANCED SUPPLY OPERATION

The LM358 will operate satisfactorily in balanced supply operation so long as a load is maintained from output to the negative supply.



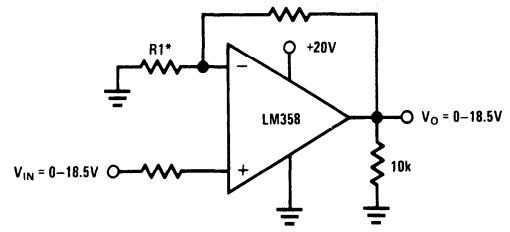
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FIGURE 3. Typical DC Coupled Inverting Gain



* $R1 = \infty$ for $A_V = +1$
 $A_V \leq 5.4$ for 20V Supply

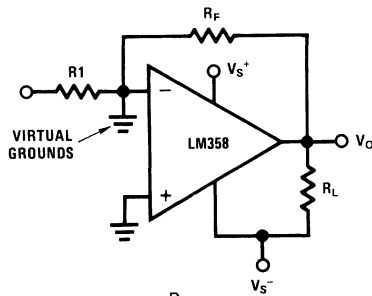
TL/H/7424-7



* $R1 = \infty$ for $A_V = +1$
 A_V not limited

TL/H/7424-8

FIGURE 4. Typical DC Coupled Non-Inverting Gain



Crossover (distortion) occurs at $V_O = V_S^- \frac{R_F}{R_L + R_F}$

TL/H/7424-9

FIGURE 5. Split Supply Operation of LM358

The output load to negative supply forces the amplifier to source some minimum current at all times, thus eliminating crossover distortion. Crossover distortion without this load would be more severe than that expected with the normal op amp. Since the single supply design took notice of this normal load connection to ground, a class AB output stage was not included. Where ground referenced feedback resistors are used as in *Figure 5*, the required load to the negative supply depends upon the peak negative output signal level desired without exhibiting crossover distortion. R_L to the negative rail should be chosen small enough that the voltage divider formed by R_F and R_L will permit V_O to swing negative to the desired point according to the equation:

$$R_L = R_F \frac{V_S - V_O}{V_O}$$

R_L could also be returned to the positive supply with the advantage that V_O max would never exceed $(V_S^+ - 1.5V)$. Then with $\pm 15V$ supplies $R_{L \text{ MIN}}$ would be $0.12 R_F$. The disadvantage would be that the LM358 can source twice as much current as it can sink, therefore R_L to negative supply can be one-half the value of R_L to positive supply.

The need for single or split supply is based on system requirements which may be other than op amp oriented. However if the only need for balanced supplies is to simplify the biasing of op amps, there are many systems which can find a cost effective benefit in operating LM358's from single supplies rather than standard op amps from balanced supplies. Of the usual op amp circuits, Table II shows those few which have limited function with single supply operation. Most are based on the premise that to operate from a single supply, a reference V_Q at about one-half the supply be available for bias or (zero) signal reference. The basic circuits are those listed in AN-20.

TABLE II. Conventional Op Amp Circuits Suitable for Single Supply Operation

Application	Limitations
AC Coupled amp‡	V_Q^*
Inverting amp	V_Q
Non-inverting amp	OK*
Unity gain buffer	OK
Summing amp	V_Q
Difference amp	V_Q
Differentiator	V_Q
Integrator	V_Q
LP Filter	V_Q
I-V Connector	V_Q
PE Cell Amp	OK
I Source	$I_{O \text{ MIN}} = \frac{1.5}{R_1}$
I sink	OK
Volt Ref	OK
FW Rectifier	V_Q or modified circuit
Sine wave osc	V_Q
Triangle generator	V_Q
Threshold detector	OK
Tracking, regulator PS	Not practical
Programmable PS	OK
Peak Detector	OK to $V_{IN} = 0$

‡See AN20 for conventional circuits

* V_Q denotes need for a reference voltage, usually at about $\frac{V_S}{2}$

OK means no reference voltage required

LM143 Monolithic High Voltage Operational Amplifier Applications

National Semiconductor
Application Note 127



INTRODUCTION

The LM143 is a general purpose, high voltage operational amplifier featuring $\pm 40V$ maximum supply voltage operation, output swing to $\pm 37V$, $\pm 38V$ input common-mode range, input overvoltage protection up to $\pm 40V$ and slew rate greater than $2V/\mu s^*$. Offset null capability plus low input bias and offset currents (8 nA and 1 nA respectively) minimize errors in both high and low source impedance applications. Due to isothermal symmetry of the chip layout, gain is constant for loads $\geq 2 k\Omega$ at output levels to $\pm 37V$. Because of these features, the LM143 offers advantages not found in other general purpose op amps. The LM143 may, in fact, be used as an improved performance, plug-in replacement for the LM741 in most applications.

This paper describes the operation of the LM143 and presents applications which take advantage of its unique, high voltage capabilities. Obviously, other applications exist where the low input current and high slew rate of the LM143 are useful. (See AN-29 on the LM108.) Application tips are included in the appendix to guide the user toward reliable, trouble-free operation.

CIRCUIT DESCRIPTION

A simplified schematic of the LM143, shown in *Figure 1*, illustrates the basic circuit operation. The super- β input transistors⁽¹⁾, Q1 and Q2, are used as emitter followers to achieve low input bias currents. Although these devices exhibit $\beta = 2000-5000$, they inherently have a low collector-base breakdown voltage of about 4V. Therefore, active voltage clamps Q3 and Q4 protect Q1 and Q2 under all input

conditions including common-mode and differential overvoltage. Other NPNs in the circuit are representative of those found in standard IC op amps ($\beta \approx 200$, $LV_{CEO} = 50-70V$).

The input stage differential amplifier Q7 and Q8 with large base width exhibit $LV_{CEO} = 90V$ to $110V$ and high BV_{EBO} so readily withstand input overvoltages. The total input stage collector current ($I_1 = 80 \mu A$) is made higher than in most op amps to improve slew rate. Emitter degeneration resistors, R10 and R11, reduce transconductance⁽²⁾ to limit small signal bandwidth at 1 MHz for a phase margin of 75° . Q16 and Q17 function as active collector loads for Q7 and Q8 and provide differential to single-ended current conversion with full differential gain.

One of the highest breakdown voltages available in standard planar NPN processing is the collector-base, BV_{CBO} which is typically 90V to 120V. To make use of this high voltage capability in the active region, the second stage consists of a cascode (common emitter-common base pair) connection of Q21 and Q23. The internal voltage bias V_{B1} , shunts avalanche-induced leakage current away from the base of Q21, avoiding β multiplication as found in the LV_{CEO} mode. Q23 and emitter follower Q22 are internally biased at a low voltage so the BV_{CEO} mode is impossible. Frequency compensation is achieved with an internal, high voltage capacitor, C_C .

* An externally compensated version of the LM143, the LM144, offers even higher slew rate in most applications. The LM144 is pin-for-pin compatible with the LM101A.

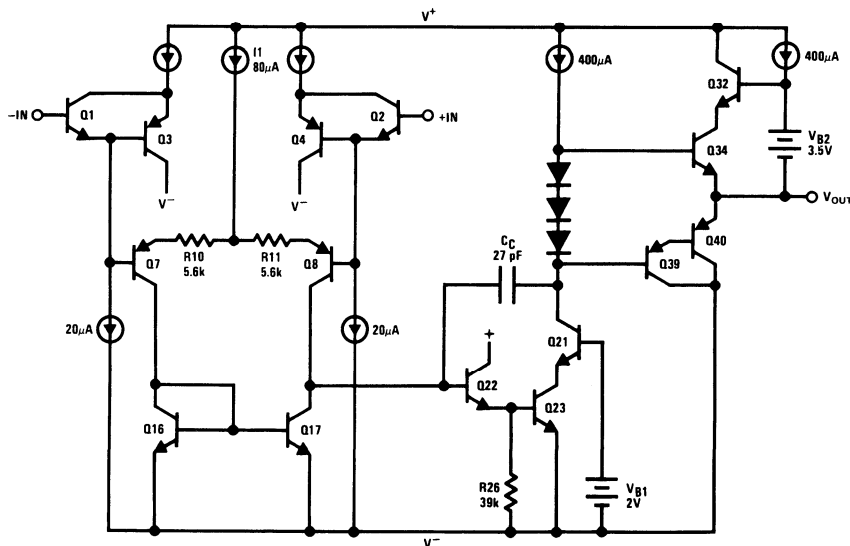


FIGURE 1. LM143 Simplified Schematic

TL/H/7432-1

The second stage drives a complementary class AB output stage. A cascode connection of Q32 and Q34 is again employed for high breakdown voltage. The associated voltage bias, V_{B2} , is internally derived. A Darlington PNP pair, Q39 and Q40 with $BV_{CEO} = 100V$, provides the active pull-down.

HIGH VOLTAGE APPLICATIONS

The following applications make use of the high voltage capabilities of the LM143. As with most general purpose op amps, the power supplies should be adequately bypassed to ground with 0.1 μF capacitors.

130 Vp-p Drive to a Floating Load

A circuit diagram using two LM143's to drive up to 130V peak-to-peak is given in Figure 2.

A non-inverting voltage amplifier, with a gain of $A_V = 1 + (R_2/R_1)$, is followed by a unity gain inverter. The load is applied across the outputs of A1 and A2. Therefore, $V_{OUT} = V_1 - V_2 = V_1 - (-V_1) = 2V_1$. If $V_1 = 65$ Vp-p, then $2V_1 = 130$ Vp-p.

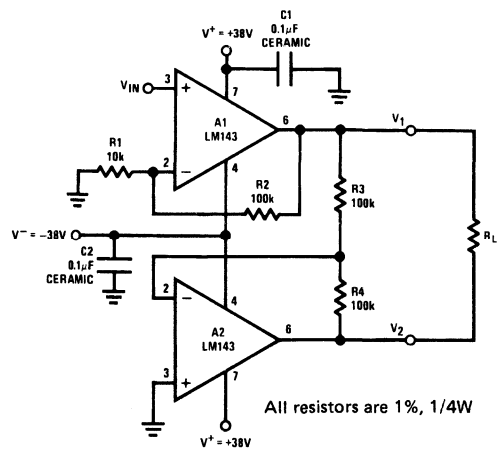
The above circuit was breadboarded and the results are as follows:

- i) Maximum output voltage: 138 Vp-p unclipped into 10 k Ω load
- ii) Slew rate: 6V/ μ s

$\pm 34V$ Common-Mode Range Instrumentation Amplifier

An instrumentation amplifier with $\pm 34V$ common-mode range, high input impedance and a gain of X1000 is shown in Figure 3.

For a differential input signal, V_{IN} , A1 and A2 act as non-inverting amplifiers of gain $A_{V1} = 1 + (2R_1/R_2)$, where $R_1 = R_3$. However, the gain is unity for common-mode



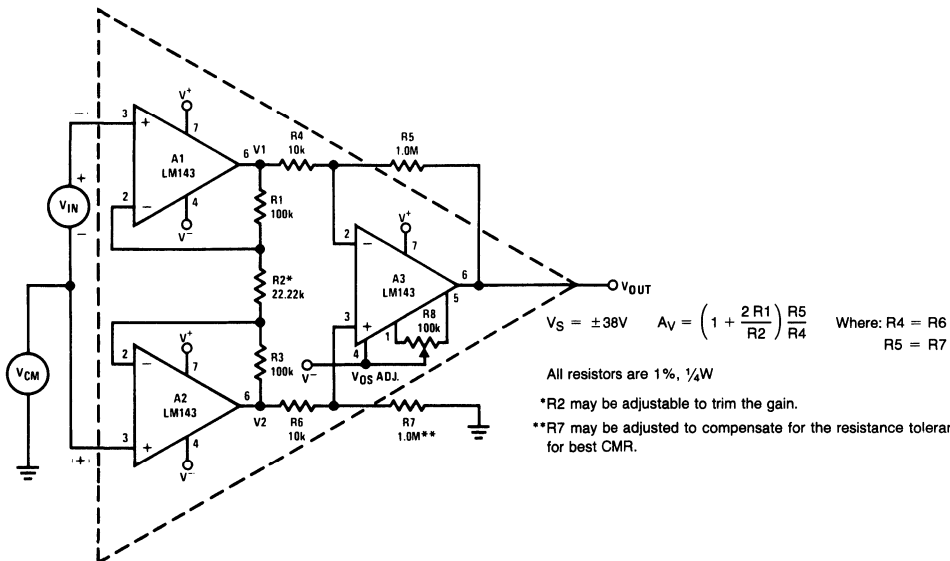
TL/H/7432-2

FIGURE 2. 130V Drive Across a Floating Load

signals since voltages V_1 and V_2 are in phase, and no current flow is developed through R_1 , R_2 and R_3 . The second stage is simply an op amp connected as a simple differential amplifier of gain, $A_{V2} = (R_5/R_4)$, where $R_5 = R_7$ and $R_4 = R_6$. The total gain of the instrumentation amplifier is

$$A_V = \left(1 + \frac{2R_1}{R_2}\right) \left(\frac{R_5}{R_4}\right) = \left(1 + \frac{2 \times 100k}{22.22k}\right) \left(\frac{1.0M}{10k}\right) = 1000$$

R_7 may be adjusted to take up the resistance tolerances of R_4 , R_5 and R_6 for best common-mode rejection (CMR). Also, R_2 may be made adjustable to vary the gain of the instrumentation amplifier without degrading the CMR.

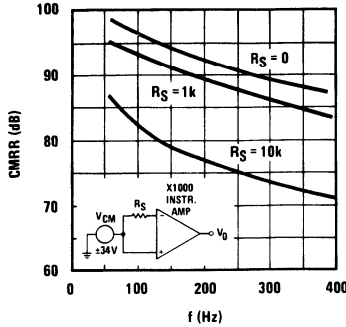


TL/H/7432-3

FIGURE 3. Wide Common-Mode Range Instrumentation Amplifier

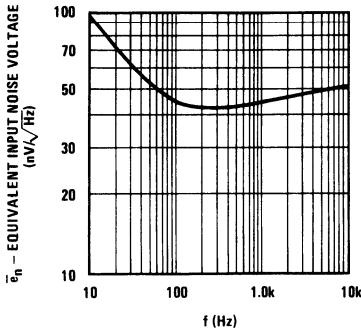
Laboratory evaluation of this circuit revealed noise and CMR data as follows:

- i) Frequency response with 10k load and $A_V = 1000$: -3.0 dB at 8.9 kHz
- ii) CMR measurements (common-mode signal of ± 34 Vp-p) in *Figure 4*
- iii) Noise measurements in *Figure 5*



TL/H/7432-4

FIGURE 4. Common-Mode Rejection Measurements

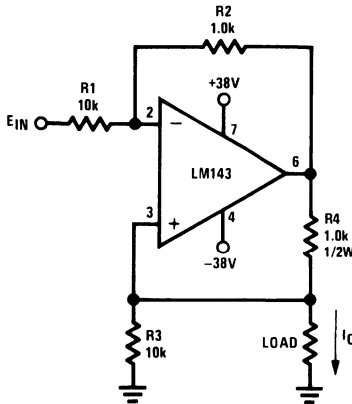


TL/H/7432-5

FIGURE 5. Noise Measurements

High Compliance Current Source

A current source with a compliance of ± 28 V is shown in *Figure 6*.



TL/H/7432-6

All resistors 1% metal film, 1/4W unless otherwise specified.

FIGURE 6. High-Compliance Current Source

The non-inverting input of the op amp senses the current through R4 to establish an output current, I_O proportional to the input voltage. The expression for I_O is

$$I_O = - \frac{E_{IN} R_2}{R_1 R_4} = - \frac{0.1 \text{ mA}}{V} E_{IN}$$

R3 keeps the circuit stable under any value of load resistance. Measured circuit performance is as follows:

$$I_{O\text{MAX}} = \pm 3.5 \text{ mA at } E_{IN} = \pm 35\text{V}$$

$$R_{OUT} = 2 \text{ M}\Omega \text{ at } I_{OUT} = \pm 2.0 \text{ mA}$$

CURRENT BOOSTED APPLICATIONS

Because of the high voltage capability of the LM143, some thought must be given for the selection of the minimum load resistance. At an ambient temperature of 25°C, the LM143 can dissipate 680 mW. Worst case dissipation arises when the load resistance R_L is connected to one supply and $V_O = 0$. Then the amplifier sources $I_O = (38\text{V}/R_L)$ with 38V internal voltage drop. During this condition,

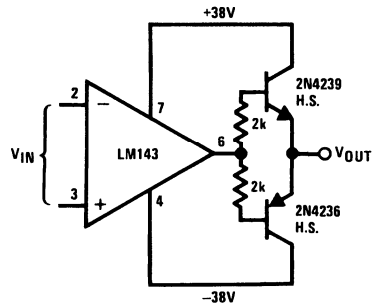
$$P_{\text{MAX}} = 680 \text{ mW} = \frac{E_L^2}{R_L} = \frac{(38\text{V})^2}{R_L}$$

$$\text{or } R_L = \frac{1444\text{V}^2}{680 \text{ mW}} \approx 2.1 \text{ k}\Omega$$

Hence, load resistances less than 2k will cause excessive power dissipation.

Simple Power Boost Circuit

For loads less than 2 k Ω , a power boost circuit should be added. The simple booster shown in *Figure 7* has the advantage of minimal parts count, but crossover distortion is noticeable and there is no short circuit protection; hence, either the LM143 or the boost transistors may fail under short circuit conditions.



TL/H/7432-7

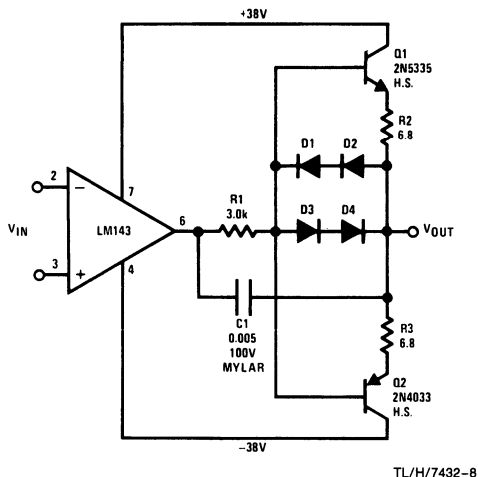
Heat sink is a Thermalloy No. 2230-5 or equivalent.

All resistors are 10%, 1W.

FIGURE 7. Simple Power Boost Circuit

100 mA Current Boost Circuit

With the addition of 4 diodes, a resistor and a capacitor, the booster circuit can be short circuit protected at 100 mA as shown in Figure 8.



TL/H/7432-8

Heat sink is a Thermalloy No. 2230-5 or equivalent.
All diodes are 1N914.
All resistors are 1/2W, 10%.

FIGURE 8. 100 mA Current Boost Circuit

R1 protects the LM143 by limiting the maximum drive current to $(38V/3.0k) \approx 12.5$ mA, thereby keeping safely within the device dissipation limit of 680 mW. D1—D4 in conjunction with R2 and R3 protect the output transistors Q1 and Q2 by shunting the output drive current if the voltage drop across R2 or R3 exceeds 0.7V.

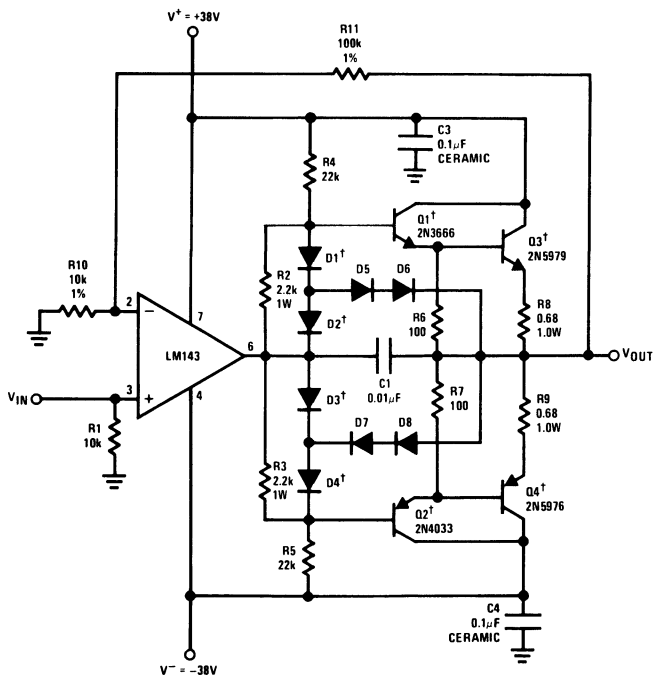
Breadboard Data:

- i) Frequency Response: Limited by LM143 frequency response and slew rate.
- ii) Step response for unity gain, voltage follower configuration: Less than 10% overshoot for 1.0V step with 0.01 μ F capacitive load, 50% overshoot with 0.47 μ F capacitive load. The circuit is unconditionally stable for capacitive loads.
- iii) Output Voltage: ± 33 Vp-p into 400 Ω load

1.0 Amp Class AB Current Booster

If crossover distortion is objectionable and currents of up to 1.0A are needed, the circuit in Figure 9 should be used.

The output of the LM143 drives a class AB complementary output stage. The quiescent current for the output stage is set by the current flow through R4, R5 and diodes D1—D4. The diodes D1—D4 are on a common heat sink with the output transistors Q3 and Q4 so that the voltage drops across the diodes and base-emitter junctions of the output



TL/H/7432-9

†Put on common heat sink, Thermalloy 6006B or equivalent.
All diodes are 1N3193.
All resistors are 10%, 1/4W except as noted.

FIGURE 9. 1 Amp Class AB Current Booster with Short Circuit Protection

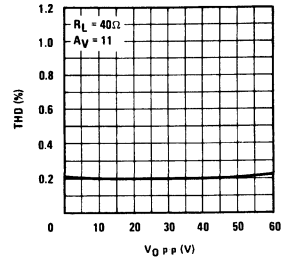
transistors will track with temperature. Normally, R4 and R5 supply the current drive for the output Darlington's, Q1, Q3 and Q2, Q4, but if additional drive is needed, the LM143 supplies the remainder through R2 and R3. For short circuited load, the drive current is bypassed around the output transistors through D1, D5 and D6 during the positive half cycle and through D4, D7 and D8 during the negative half cycle. Drive current bypassing, or output current limiting, occurs whenever R8 or R9 sees more than one diode drop ($\approx 0.7V$). An expression for the maximum output current is

$$I_{MAX} \approx \frac{0.7V}{0.68\Omega}$$

$$I_{MAX} \approx 1.0A.$$

Capacitor C1 stabilizes the circuit under most feedback and load conditions and C3 and C4 bypass the power supply. Measured performance is as follows:

- i) Maximum output voltage with $R_L = 40\Omega$: +29.6V, -28V with $V_S = \pm 38 V_{DC}$.
- ii) Harmonic distortion measurements of *Figure 10* were measured with a closed loop gain of 10.

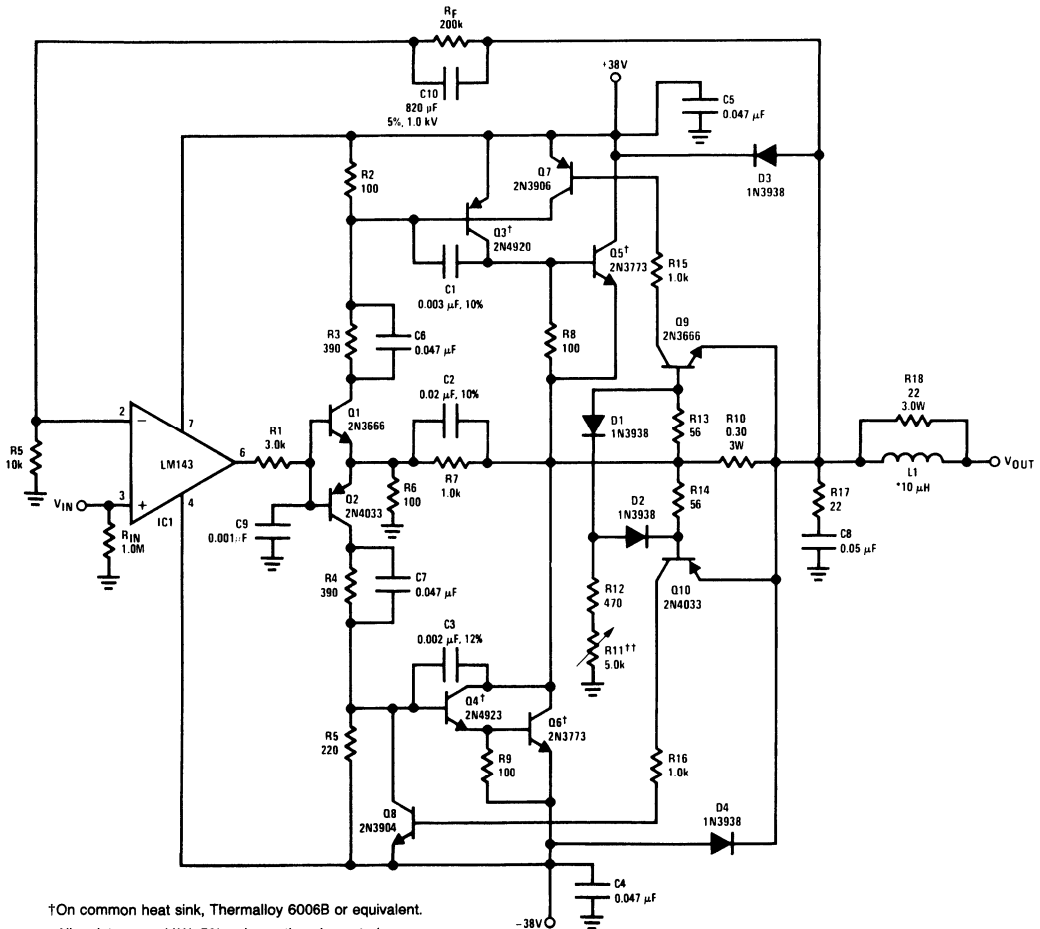


TL/H/7432-10

FIGURE 10. Harmonic Distortion Measurements

Very High Current Booster with High Compliance

If very high peak drive current is required in addition to a capability for the output swing to within 4.0V of the supplies under full load, the circuit in *Figure 11* should be used.



†On common heat sink, Thermalloy 6006B or equivalent.
 All resistors are 1/2W, 5% unless otherwise noted.
 All capacitors are 20%, 100V, ceramic disc unless otherwise noted.
 ††Output current limit adjust.

TL/H/7432-11

FIGURE 11. Very High Current Booster with High Compliance

Excluding the LM143, the current booster has three stages. The first stage is made up of Q1 and Q2 which level shifts and boosts the current output of the LM143 to about 100 mA. Q3 and Q4 further boost the output of Q1 and Q2 to about 1.0A. Q5 and Q6 then have adequate drive to source and sink at least 10A. There is no quiescent current path when the output voltage is zero since Q1 and Q2 are biased off.

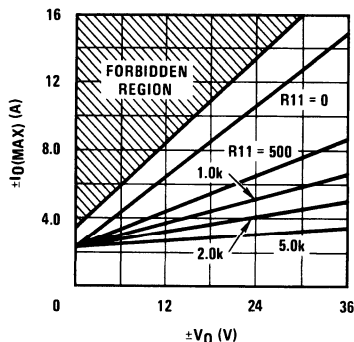
The short circuit protection circuit is made up of Q7 and Q9 on the positive side and Q8 and Q10 on the negative side. Q9 or Q10 turns on as soon as $V_{BE} \cong 0.7V$ appears across R10 when the output terminal is shorted to ground. Then Q7 or Q8 bypass the drive to the output devices, Q5 and Q6. Since R10 is 0.3Ω , current limiting under short circuited output occurs at 2.3A and is relatively independent of the current limit adjustment resistor, R11. An expression for the maximum output current, $I_{OUT\ MAX}$, with V_{OUT} and R11 as variables is

$$|I_{OUT\ MAX}| \cong \frac{(|V_{OUT}| - V_{D1}) R_{13}}{R_{11} + R_{12} + R_{13}} + V_{BE9}$$

$$\cong \frac{(|V_{OUT}| - 0.7) 56\Omega}{R_{11} + 526\Omega} + 0.7V$$

$$\cong \frac{(|V_{OUT}| - 0.7) 56\Omega}{0.3\Omega} + 0.7V$$

The equation is valid for both output polarities. The plot in *Figure 12* superimposes the above equation on the maximum operating area curve for the 2N3773 and illustrates the safe area protection feature.



TL/H/7432-12

FIGURE 12. Maximum Output Current as a Function of R11 and V_{OUT}

The diodes, D1 and D2, are in the circuit to keep the base-emitter junctions of Q9 and Q10 from being reversed biased during the opposite polarity output voltage swings. C1, C2, C3, C6, C7 and C9 are judiciously inserted in the circuit to prevent oscillation. R17, R18, C8 and L1 are used in the circuit to maintain stability under all load conditions. Diodes D3 and D4 provide protection for inductive loads.

All measurements taken with a 4Ω load and $\pm 38V$ supplies unless otherwise stated:

- i) Maximum power out: 144 Wrms
- ii) Frequency response:
 - a) -3.0 dB at 10 kHz at full power
 - b) -3.0 dB at 11.5 kHz at 10 Vp-p out
- iii) Maximum output voltage: $\pm 34V$
- iv) Maximum capacitive load: 10 μF with 10% overshoot for a small signal step response
- v) DC deadband: 20 μV
- vi) Quiescent current: 12.7 mA (positive supply), 2.1 mA (negative supply)
- vii) Input impedance: 1 M Ω
- viii) Voltage gain: 21

HIGH POWER APPLICATIONS

90 Wrms Audio Power Amplifier

A circuit diagram of an audio power amplifier which is capable of 90 Wrms into a 4Ω speaker or 70 Wrms into an 8Ω speaker is given in *Figure 13*. The circuit features safe area, short circuit and overload protection, harmonic distortion less than 0.1% at 1.0 kHz, and an all NPN output stage.

The output of the LM143 drives a quasi-complementary output stage made up of Q1, Q2, Q3 and Q4. This quasi-complementary circuit, which makes possible an all NPN output, was chosen over the complementary output circuit due to the lack of low cost high voltage power PNP transistors.

Safe area current limiting occurs whenever the output current is

$$|I_{OUT\ MAX}| = \frac{(|V_{OUT}| - V_{D3}) R_{11}}{R_{11} + R_{13}} + V_{BE5}$$

$$\cong \frac{(|V_{OUT}| - V_{D3}) R_{11}}{R_{12}}$$

where $R_{11} = R_{15} = 330\Omega$,

$R_{13} = R_{14} = 3.9k$,

$R_{12} = R_{16} = 0.25\Omega$ and

$V_{BE5} \cong V_{BE6} \cong V_{D3} \cong V_{D4} \cong 0.7V$.

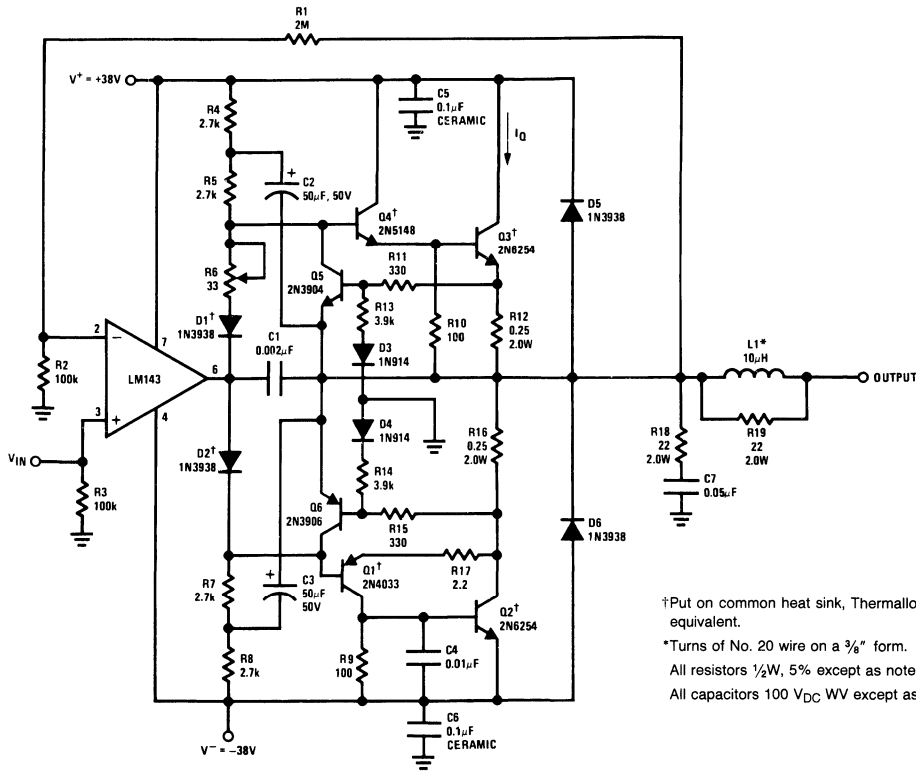
If the output is shorted, the above equation simplifies to

$$I_{OUT\ MAX} = \frac{V_{BE5}}{R_{12}} \cong \frac{0.7V}{0.25\Omega} = 2.8A$$

If the output voltage is 30V,

$$I_{OUT\ MAX} = \frac{(30V - 0.7V) 330}{4.23k} + 0.7V$$

$$\cong \frac{2.3 + 0.7V}{0.25} = 12A$$



†Put on common heat sink, Thermalloy 6006B or equivalent.
 *Turns of No. 20 wire on a 3/8" form.
 All resistors 1/2W, 5% except as noted.
 All capacitors 100 V_{DC} WV except as noted.

FIGURE 13. 90W Audio Power Amplifier

TL/H/7432-13

The maximum output current, $I_{O(MAX)}$, versus V_O is plotted in Figure 14. D4 and D3 are in the circuit to keep Q5 off during the negative half of the output voltage cycle and Q6 off during the positive half cycle.

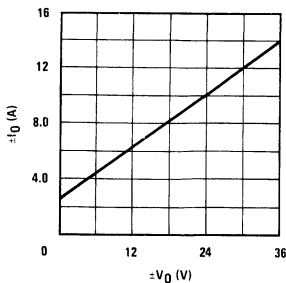


FIGURE 14. Output Current Limiting as a Function of Output Voltage

TL/H/7432-14

The output stage is biased into class AB operation by using the resistor string R4, R5, R7 and R8 to set the voltage drops across R6, D1 and D2, which then determine the quiescent current through the output transistors. These diodes are thermally coupled to the output devices to track their base-emitter junction voltages with temperature. Low distortion at low power levels is achieved by adjusting R6 to set the quiescent current through Q3 and Q2 to about 100 mA.

Figure 15 shows a plot of distortion at 50 mW versus quiescent current. C2 and C3 are connected between the output and the R4, R5 and R7, R8 junctions to provide a "boot-strapped" drive potential for the output stage during output voltage swings near the power supply potentials. The absolute magnitudes of the voltages at these junctions exceed the power supply voltages during the high outputs swings so that adequate current drives to Q4 and Q1 are available. C1 and C4 are used for compensating the output stage. C5 and C6 are used for power supply bypassing. R18, C7, R19 and L1 are included in the circuit to keep the amplifier stable under all load conditions. D5 and D6 provide protection for inductive loads.

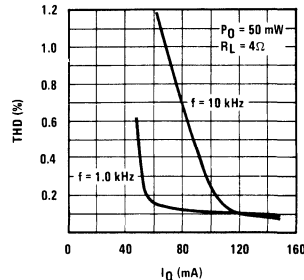


FIGURE 15. Quiescent Current vs Distortion

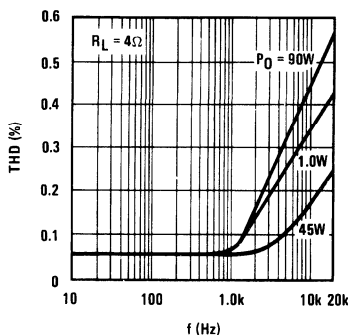
TL/H/7432-15

The input impedance of the audio amplifier is simply the value of R3. To keep the output offset voltages to a minimum, $R3 \cong R1 \parallel R2$. The voltage gain is

$$A_V = 1 + \frac{R1}{R2} = 1 + \frac{2.0M}{100k} = 21$$

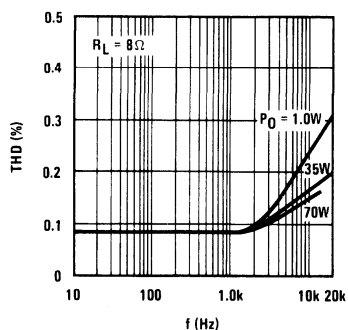
The following data was taken with $V_S = \pm 38V$:

- i) Maximum power output before visible clipping:
 - a) 90 Wrms at 1.0 kHz into 4 Ω load
 - b) 70 Wrms at 1.0 kHz into 8 Ω load
- ii) Distortion measurement: distortion versus frequency and power is plotted in *Figures 16 and 17*.
- iii) Maximum capacitive load: 20 μF
- iv) Output noise, 10 Hz to 20 kHz: 100 μV rms
- v) Frequency response:
 - a) Small signal (1.0 Vrms into 4.0 Ω): -3.0 dB at 40 kHz
 - b) Power (90W into 4 Ω): -3.0 dB at 29 kHz
 - c) Power (70W into 8 Ω): -3.0 dB at 30 kHz



TL/H/7432-16

FIGURE 16. Distortion vs Frequency, $R_L = 4\Omega$



TL/H/7432-17

FIGURE 17. Distortion vs Frequency, $R_L = 8\Omega$

POWER SUPPLY CIRCUITS

The ability of the LM143 to withstand up to 80V can be exploited fully in the design of regulated power supplies. The circuits to be described use a zener reference voltage, an IC voltage amplifier, and a discrete power transistor pass element. If care is taken to keep the voltage drop across the

pass element within 40V, standard three terminal voltage regulators such as the LM340, LM120, etc. may be used as pass elements and significantly decrease parts count and circuit complexity. Circuits using this approach are given in the LM340 application note (see AN-103).

A Tracking $\pm 65V$ Supply with 500 mA Output

A tracking power supply circuit can be made by modifying the circuit for the 130 Vp-p driver circuit. The modified circuit is given in *Figure 18*.

A 2N4275 is used as a stable zener voltage reference of about 6.5V. Its output is amplified from one to about 10 times by the circuitry associated with IC1. The output of IC1 is applied through R10 to the Darlington connected transistors, Q2 and Q3. The feedback resistor, R5, one end of which is connected to the V^+ output node, is made variable so that the V^+ output voltage will vary from 6.5V to about +65V. The V^+ output is applied to a unity gain inverting power amplifier to generate the V^- output voltage. The output circuit of the unity gain inverter uses a composite PNP, Q4 and Q5, to provide the current boost.

Since the input terminals of A2 are at ground potential, the positive supply lead cannot be grounded; instead, it is connected to the output of a 4.7V zener diode, D8, to keep within the input common-mode range.

C1, C3 and C4 are used for decreasing the power supply noise. C2 is used in bypassing most of the noise generated by the reference voltage and C5 and C6 are used to reduce the voltage output noise. Short circuit protection is provided by D1, D2, D3, R10 and R14 on the positive side and by D4, D5, R11 and R15 on the negative side. The short circuit protection circuit is the same as the one used in the 1.0A current booster circuit.

The short circuit current is given by

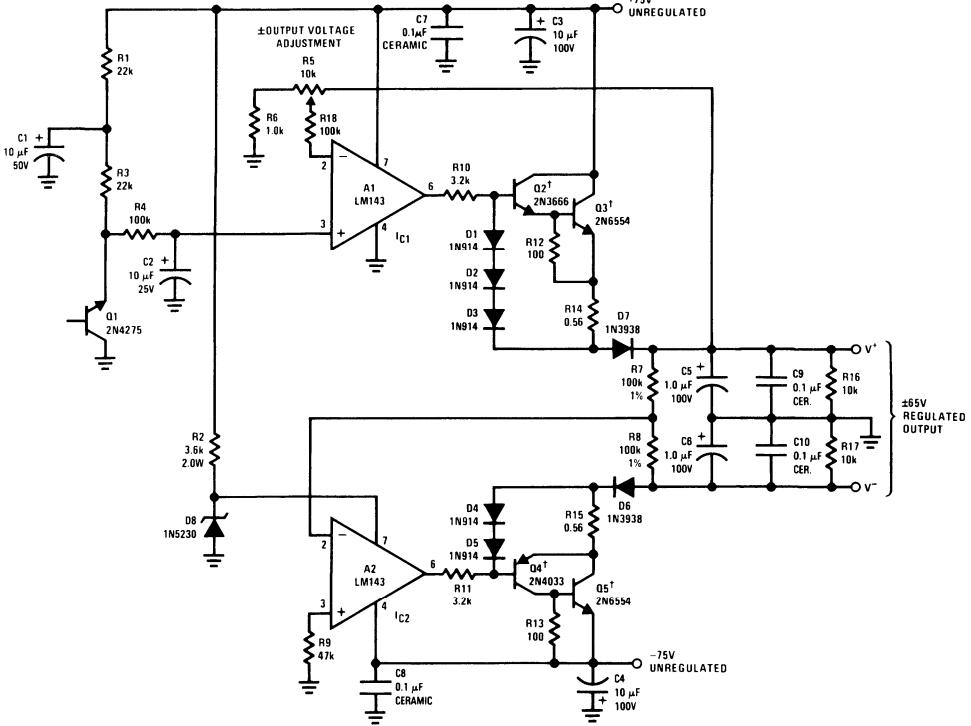
$$I_{MAX} \cong \frac{V_{BE}}{R14} \cong \frac{V_{BE}}{R15} \\ \cong \frac{0.7}{0.56} = 1.25A$$

where V_{BE} = voltage drop across a diode.

$\pm 65V$, 1.0A Power Supply with Continuously Variable Output Current and Voltage

If a continuously variable output current as well as output voltage supply is needed, a power supply circuit given in *Figure 19* will do the job. It has an output range from 7.1V to 65V with an adjustable output current range of 0 to 1.0A.

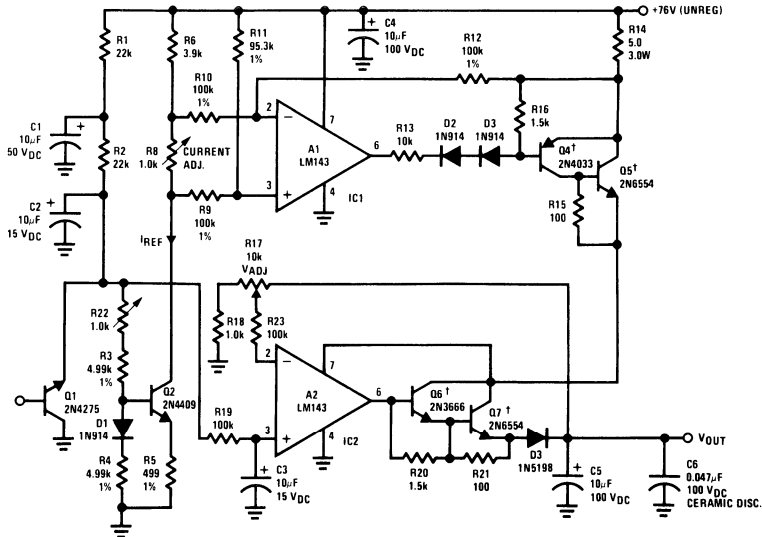
Basically, the power supply circuit is a non-ideal voltage source in series with a non-ideal current source. A reference voltage of approximately 6.5V is obtained by zenering the base-emitter junction of the 2N4275. The positive temperature coefficient of the zenering voltage is compensated by the negative temperature coefficient of the forward biased base-collector junction. The output of the voltage reference goes to the variable gain power amplifier made up of IC2, Q6, Q7 and their associated components and to a reference current source made up of Q2, D1 and components around them. The variable gain power amplifier multiplies the reference voltage from one to ten times due to the variable feedback resistor, R17. since the maximum current output of IC2 is at most 20 mA, the Darlington connected Q6 and Q7 are used to boost the available output current to 500 mA.



†Put on common heat sink, Thermalloy 6006B or equivalent.
 All resistors are 1/2W, 5%, except as noted.

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FIGURE 18. Tracking 65V, 1A Power Supply with Short Circuit Protection



†Put on common heat sink, Thermalloy 6006B or equivalent.
 All resistors 1/2W, 10% unless otherwise noted.
 All capacitors 20%.

TL/H/7432-19

FIGURE 19. 1A, 65V Power Supply with Variable Current Limit

Breadboard Data for the Tracking 65V Power Supply

$V_{IN} = \pm 75V$, $I_{OUT} = \pm 500$ mA, $T_j = 25^\circ C$, $T_A = 25^\circ C$, $V_{OUT} = \pm 40V$, unless otherwise specified.

Parameter	Conditions	Measured Data	
		+ V_{OUT}	- V_{OUT}
Load Regulation	$0 \leq I_{OUT} \leq 500$ mA	0.5 mV	1.0 mV
Line Regulation	$ \pm 50V \leq V_{IN} \leq \pm 80V $ $I_{OUT} = \pm 100$ mA $I_{OUT} = \pm 500$ mA	175 mV 169 mV	176 mV 173 mV
Quiescent Current	$I_{OUT} = 0$	Pos. Supply 28.22 mA	Neg. Supply 6.55 mA
Output Noise Voltage*	10 Hz $\leq f \leq 100$ kHz	0.125 mV	0.135 mV
Ripple Rejection	$I_{OUT} = \pm 20$ mA, $f = 120$ Hz	-72.5 dB	-63.4 dB
Output Voltage Drift*		3.38 mV/ $^\circ C$	3.43 mV/ $^\circ C$

*The output noise and drift are due primarily to the zener reference.

Measured Performance of the 1A, 65V Power Supply

$V_{IN} = +76V$, $I_{OUT} = 500$ mA, $T_j = 25^\circ C$, $V_{OUT} = +40V$ unless otherwise specified

Parameter	Conditions	Measured Data
Load Regulation	$0 \leq I_{OUT} \leq 500$ mA (Pulsed Load)	5.0 mV
Line Regulation	$46V \leq V_{IN} \leq 76V$ $I_{OUT} = 100$ mA $I_{OUT} = 500$ mA (dc Loads)	297 mV 286 mV
Maximum Output Voltage	dc Load	68.6V
Quiescent Current		21.4 mA
Output Noise Voltage*	10 Hz $\leq f \leq 100$ kHz	0.280 mV
Ripple Rejection	$I_{OUT} = 20$ mA $f = 120$ Hz $\Delta V_S = 3.0$ Vp-p $\Delta V_O = 6.0$ mVp-p	66.6 dB
Loads are Pulsed Loads	200 μs Pulse Every 200 ms	

*The output noise is due primarily to zener reference

The power current source is an op amp used as a differential amplifier which senses the voltage drop across R8 and maintains this same voltage across R14. Hence, the maximum output current is

$$I_{OUT} = \frac{R8}{R14} \times I_{REF} \leq \frac{1.0k}{5.0\Omega} \times 5.0 \text{ mA} = 1.0A.$$

Since the output load under most conditions will not demand what the power current source can deliver, Q4 and Q5 will remain in saturation during normal operation. When Q4 and Q5 are pulled out of saturation, the output load voltage will drop until the load current just equals what is avail-

able from the power current source. Because the positive supply terminal of IC2 is tied to the collectors of Q4 and Q5, IC2 will supply just enough current drive to Q6 and Q7 to keep itself on. Hence, a current limiting resistor is unnecessary for IC2. A 10k current limiting resistor, R13, is present since the total unregulated power supply voltage is available for IC1. R6 is used to stay within the input common-mode voltage range of IC1.

I_{REF} is derived from the 6.5V reference source, Q1, by using Q2 in a current source configuration. R22 is made adjustable so that I_{REF} can be set for 5.0 mA.

CONCLUSION

The LM143 is a high performance operational amplifier suited for applications requiring supply voltages up to $\pm 40V$. The LM143 is especially useful in power supply circuits where the unregulated voltages are as high as $\pm 40V$ and in amplifier circuits where output voltages greater than $\pm 30V$ peak are needed. The LM143 is internally compensated and is pin-for-pin compatible with the LM741. Compared with the LM741, the LM143 exhibits an order of magnitude lower input bias currents, better than five times the slew rate and twice the output voltage swing.

APPENDIX

Toward the goal of trouble-free applications, this appendix details some of the more subtle features of the LM143 and reviews application hints pertinent both to op amps in general and the LM143 in particular. The complete schematic of the LM143 is shown in *Figure 20*.

The circuit starts drawing supply current, at supply voltages of $\pm 4V$, when current is provided to a 7.5V zener diode D5

by the collector FET Q41. The gate-channel junction of Q41 exhibits 100V breakdown as source and drain are lightly doped NPN collector and substrate material. The collector current of Q18 biases current sources Q25 through Q30 and sets the supply current at nearly zero TC.

Q19 furnishes a bias voltage, 5V above the negative supply, for the collectors of Q15, Q20 and Q22. The low impedance 2V reference (V_{B1} in *Figure 1*) for the base of Q21 appears at the emitter of Q20 and has the correct TC to insure that Q23 never saturates. Should this occur, the low resistance of Q23 would cause premature V_{CE0} breakdown of Q21.

The input transistors, Q1 and Q2, are biased by Q13 and Q14 which have a breakdown voltage essentially equal to BV_{CBO} by virtue of the high emitter impedance, R18 and R19, relative to the low dynamic impedance of D4. In a similar way, Q18 and Q19 stand off essentially the full supply voltage. These devices have a high output impedance caused by series feedback and so hold the supply current nearly constant to prevent excessive power dissipation at high supply voltages.

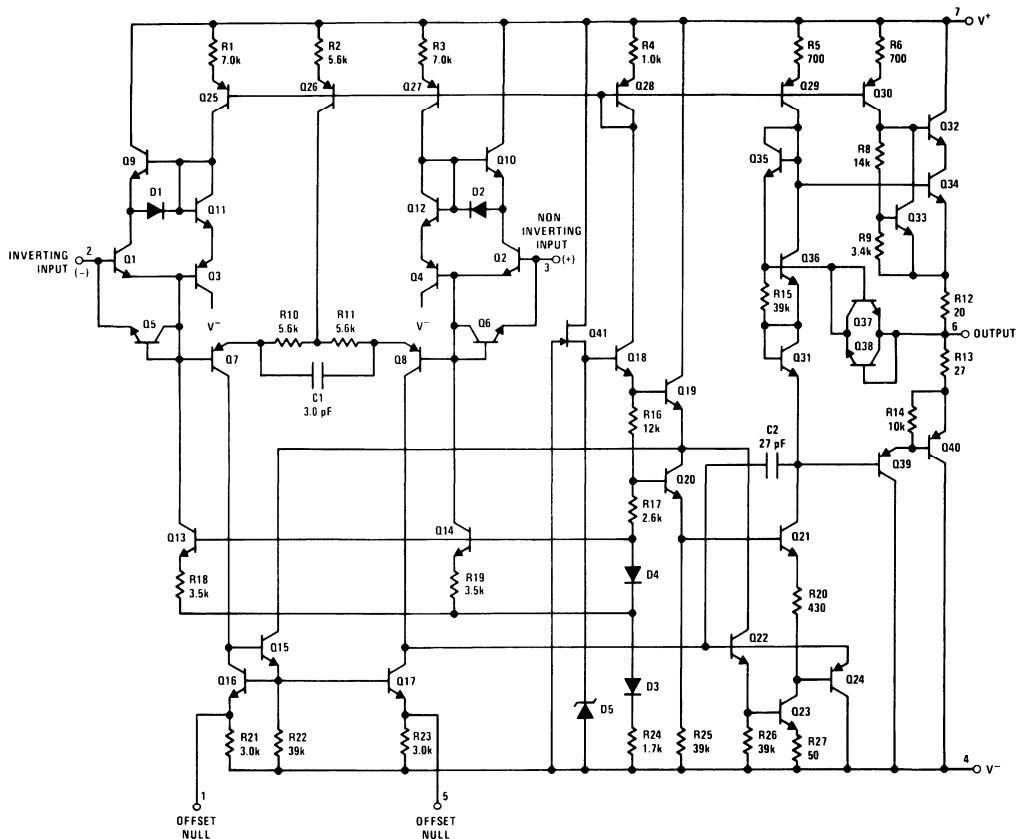


FIGURE 20. Complete Schematic of the LM143

TL/H/7432-20

While the simple voltage clamping scheme, Q3 and Q4 in *Figure 1*, is adequate, it is prone to oscillation when built with high β PNPs. The more elaborate scheme of *Figure 20* prevents instability. This clamping method is similar to that used in the LM108, but allows large differential inputs to exist with complete input overvoltage protection. Q9 and Q10, which withstand the high input common-mode voltage, have a BV_{CBO} -type breakdown due to the low impedance diodes seen from the base leads and the high impedance of Q1 and Q2 (enhanced by 100% series feedback) in the emitter leads. Input overvoltage protection also holds up under high-level transient input voltages.

With a large negative-going step input, as could occur in the unity-gain voltage follower configuration, diode-connected Q6 turns "ON", protecting the emitter-base junction of Q2 from zener breakdown and subsequent long-term β degradation. At the same time, stray capacitance at the collector of Q2 is discharged by D2 through Q4 and Q12. This holds Q10 in a true BV_{CBO} mode (emitter open-circuited) and clamps the voltage across Q2 to $3 V_{BE}$.

With a large positive-going step input, stray capacitance at the collectors of Q2 and Q12 is charged by the forward-biased collector junction of Q2. As before, with D2 conducting, Q10 is again in the BV_{CBO} breakdown mode. Since the inverting input can be subject to the same transients, Q1 is afforded the same protection.

Distributed capacitance associated with R10 and R11, together with the collector-base capacitance of Q26, cause a high frequency transmission pole (the "tail" pole⁽²⁾) which can degrade phase margin. This is avoided by adding a small lead capacitor, C1, which provides an alternative low-impedance signal path, thus bypassing the tail pole.

The offset null resistors, R21 and R23, are made larger than that strictly necessary to null the offset voltage. This reduces the transconductance of Q17 and, therefore, the noise gain of the active loads into R10 and R11. By this simple expedient, broadband input noise voltage is substantially reduced.

The voltage reference for the output stage (V_{B2} in *Figure 1*) is realized by actively simulating a 4-diode stack. The voltage across Q33, given by $(1 + R8/R9) V_{BE}$, is about 3.5V. Biased at $400 \mu A$ from Q30, the circuit presents a low im-

pedance, less than 50Ω , to the base of Q32. Since the TC of the reference is negative, Q34 is designed to always remain out of saturation under worst-case conditions of high temperature and high output current. This avoids potential destructive breakdown of Q32.

Current limiting for Q32 and Q34 is provided by diode-connected Q37 and resistor R12. When the voltage drop across R12 turns on Q37, it removes base drive from Q34. In a similar fashion, current limiting in the negative direction is initiated when the voltage drop across R13 causes Q38 to conduct. This current is limited in Q21 by R20 to about 1 mA. When this occurs, base drive is removed from Q39.

Although output short circuits to ground or either supply can be sustained indefinitely at supply voltages lower than $\pm 22V$, short circuits should be of limited duration when operating at higher supply voltages. Units can be destroyed by any combination of high ambient temperature, high supply voltages, and high power dissipation which results in excessive die temperature. This is also true when driving low impedance or reactive loads or loads that can revert to low impedance; for example, the LM143 can drive most general purpose op amps outside of their maximum input voltage range, causing heavy current to flow and possibly destroying both devices.

Precautions should be taken to insure that the power supplies never become reversed in polarity—even under transient conditions. With reverse voltage, the IC will conduct excessive current, fusing the internal aluminum interconnects. As with all IC op amps, voltage reversal between the power supplies will almost always result in a destroyed unit. Finally, caution should be exercised in high voltage applications as electrical shock hazards are present. Since the negative supply is connected to the case, users may inadvertently contact voltages equal to those across the power supplies.

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1. R. J. Widlar, "Super Gain Transistors for ICs", National Semiconductor TP-11, March 1969.
2. J. E. Solomon, "The Monolithic Op Amp: A Tutorial Study", IEEE Journal of Solid-State Circuits, Vol. SC-9, No. 6, December 1974.

FM Remote Speaker System

National Semiconductor
Application Note 146
Jim Sherwin
Tim Regan



INTRODUCTION

A high quality, noise free, wireless FM transmitter/receiver may be made using the LM566 VCO and LM565 PLL Detector. The LM566 VCO is used to convert the program material into FM format, which is then transformer coupled to standard power lines. At the receiver end the material is detected from the power lines and demodulated by the LM565.

The important difference between this carrier system and others is its excellent quality and freedom from noise. Whereas the ordinary wireless intercom uses an AM carrier and exhibits a poor signal-to-noise ratio (S/N), the system described here uses an FM carrier for inherent freedom from noise and a PLL detection system for additional noise rejection.

The complete system is suitable for high-quality transmission of speech or music, and will operate from any AC outlet anywhere on a one-acre homesite. Frequency response is 20–20,000 Hz and THD is under $\frac{1}{2}\%$ for speech and music program material.

Transmission distance along a power line is at least adequate to include all outlets in and around a suburban home and yard. Whereas many carrier systems operate satisfactorily only when transmitter and receiver are plugged into the same side of the 120–240/V power service line, this system operates equally well with the receiver on either side of the line.

The transmitter is plugged into the AC line at a radio or stereo system source. The signal for the transmitter is ideally taken from the MONITOR or TAPE OUT connectors provided on component system Hi-Fi receivers. If these outputs are not available, the signal could be taken from the main or extra speaker terminals, although the remote volume would then be under control of the local gain control. The carrier system receiver need only be plugged into the AC line at the remote listening location. The design includes a 2.5W power amplifier to drive a speaker directly.

TRANSMITTER

Two input terminals are provided so that both LEFT and RIGHT signals of a stereo set may be combined for mono transmission to a single remote speaker if desired.

The input signal level is adjustable by R_1 to prevent over-modulation of the carrier. Adding C_2 across each input resistor R_7 and R_8 improves the frequency response to 20 kHz as shown in *Figure 5*. Although casual listening does not demand such performance, it could be desired in some circumstances.

The VCO free-running frequency, or carrier frequency f_c , determined by R_4 and C_4 is set at 200 kHz which is high enough to be effectively coupled to the AC line. VCO sensitivity under the selected bias conditions with $V_S = 12V$ is about $\pm 0.66 f_c/V$. For minimum distortion, the deviation should be limited to $\pm 10\%$; thus maximum input at pin #5

of the VCO is $\pm 0.15V$ peak. A reduction due to the summing network brings the required input to about 0.2V rms for $\pm 10\%$ modulation of f_c , based on nominal output levels from stereo receivers. Input potentiometer R_1 is provided to set the required level. The output at pin #3 of the LM566, being a frequency modulated square wave of approximately 6V pk-pk amplitude, is amplified by a single transistor Q_1 and coupled to the AC line via the tuned transformer T_1 . Because T_1 is tuned to f_c , it appears as a high impedance collector load, so Q_1 need not have additional current limiting. The collector signal may be as much as 40–50V pk-pk. Coupling capacitor C_8 isolates the transformer from the line at 60 Hz.

A Voltage regulator provides necessary supply rejection for the VCO. The power transformer is sized for peak secondary voltage somewhat below the regulator breakdown voltage spec (35V) with a 125V line.

RECEIVER

The receiver amplifies, limits, and demodulates the received FM signal in the presence of line transient interference sometimes as high as several hundred volts peak. In addition, it provides audio mute in the absence of carrier and 2.5W output to a speaker.

The carrier signal is capacitively coupled from the line to the tuned transformer T_1 . Loaded Q of the secondary tank T_1C_2 is decreased by shunt resistor R_1 to enable acceptance of the $\pm 10\%$ modulated carrier, and to prevent excessive tank circuit ringing on noise spikes. The secondary of T_1 is tapped to match the base input impedance of Q_{1A} . Recovered carrier at the secondary of T_1 may be anywhere from 0.2 to 45V p-p; the base of Q_{1A} may see pk-to-pk signal levels of from 12 mV to 2.6V.

Q_{1A} – Q_{1D} operates as a two-stage limiter amplifier whose output is a symmetrical square wave of about 7V pk-pk with rise and fall times of 100 ns.

The output of the limiting amplifier is applied directly to the mute peak detector, but is reduced to 1V pk-pk for driving the PLL detector.

The PLL detector operates as a narrow band tracking filter which tracks the input signal and provides a low-distortion demodulated audio output with high S/N. The oscillator within the PLL is set to free-run at or near the carrier frequency of 200 kHz. The free-run frequency is $f_0 \approx 1/(3.7 R_{16}C_{13})$. Since the PLL will lock to a carrier near its free-run frequency, an adjustment of R_{16} is not strictly necessary; R_{16} could be fixed at 4700 or 5100 Ω . Actually, the PLL with the indicated value of C_{11} can lock on a carrier within about ± 40 kHz of its center frequency. However, rejection of impulse noise in difficult circumstances can be maximized by carefully adjusting f_0 to the carrier frequency f_c . Adding

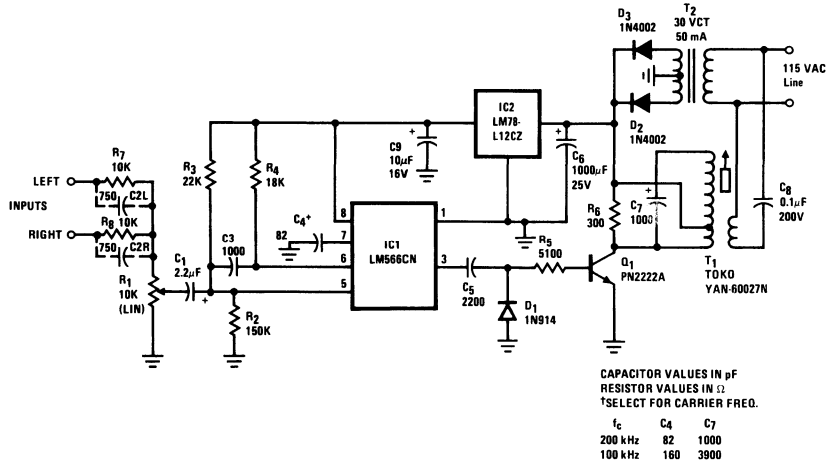


FIGURE 1. Carrier System Transmitter

TL/H/7442-1

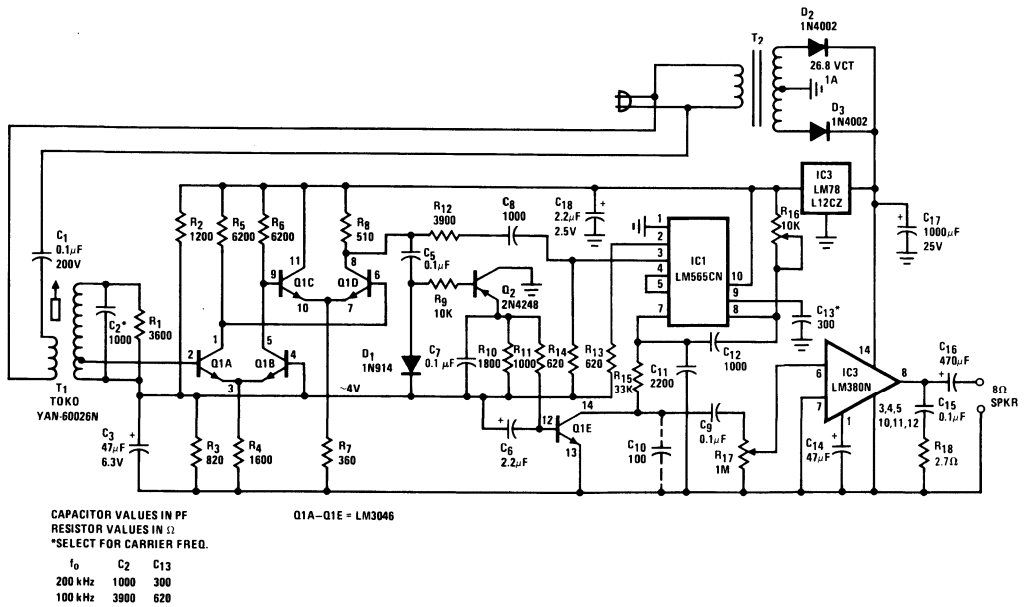


FIGURE 2. Carrier System Receiver

TL/H/7442-2

$C_{10} = 100 \text{ pF}$ will reduce the carrier level fed to the power amplifier. Even though the listener cannot hear the carrier, the audio amplifier could overload due to carrier signal power.

A mute circuit is included to quiet the receiver in the absence of a carrier. Otherwise, when the transmitter is turned OFF, an excessive noise level would result as the PLL attempts to lock on noise. The mute detector consists of a voltage doubling peak detector $D_1Q_2C_7$. The peak detector shunts the 1–2 mA bias away from Q_{1E} without loading the limiter amplifier. When no carrier is present, the +4V line biases Q_{1E} ON via R_{10} and R_{11} ; and the audio signal is shorted to ground. When a carrier is present, the 7V square wave from the limiter amplifier is peak detected*, and the resultant negative output is integrated by R_9C_7 , averaged by R_{10} across C_7 , and further integrated by $R_{11}C_6$. The resultant output of about -4V subtracts from the +4V bias supply, thus depriving Q_{1E} of base current. Peak detector integration and averaging prevents noise spikes from deactivat-

ing the mute in the absence of a carrier when the limiter amplifier output is a series of narrow 7V spikes.

The LM380 supplies 2.5W of audio power to an 8Ω load. Although this is adequate for casual listening in the kitchen or garage, for hi-fi listening, a larger amplifier may be direct.

CONSTRUCTION

PC board layout and stuffing diagrams are shown in *Figures 3 & 4*. After the receiver board has been loaded and checked, the power transformer is mounted to the foil side of the board with a piece of fish-paper or electrical insulating cloth between board and transformer. Insulating washers of $1/16$ – $1/4$ inch thickness can be used to advantage in holding the transformer away from the foil. The board is laid out so that the volume control potentiometer may be mounted on either side of the board depending on the desired mounting to a panel.

The line coupling coils are available in production quantities from TOKO AMERICA, INC. 1250 Feehanville Drive, Mount Prospect, IL 60056. TEL: (312) 297-0070

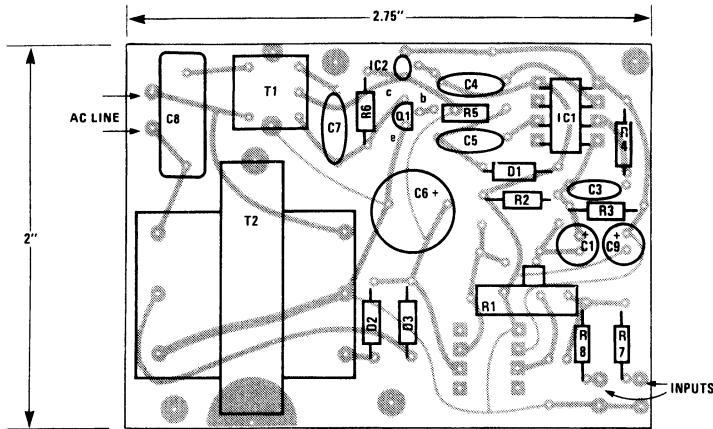


FIGURE 3. Carrier System Transmitter PC Layout and Loading Diagram (Not Full Scale)

TL/H/7442-3

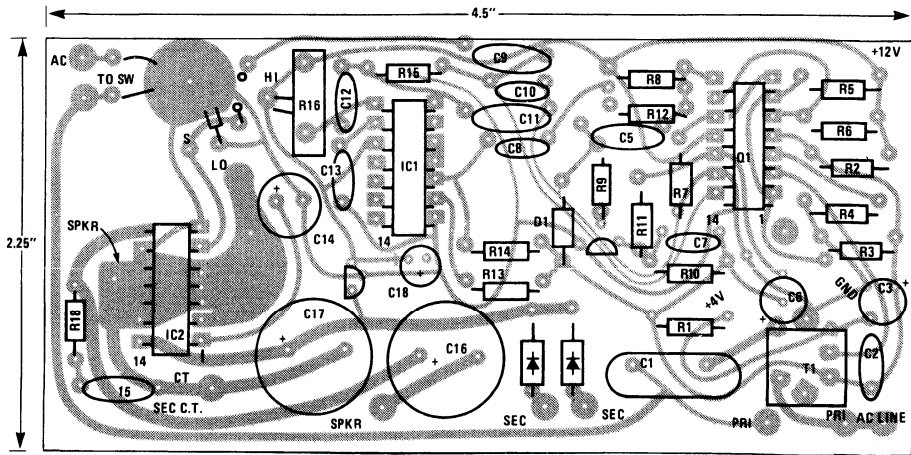


FIGURE 4. Carrier System Receiver PC Layout and Loading Diagram (Not Full Scale)

TL/H/7442-4

ADJUSTMENT

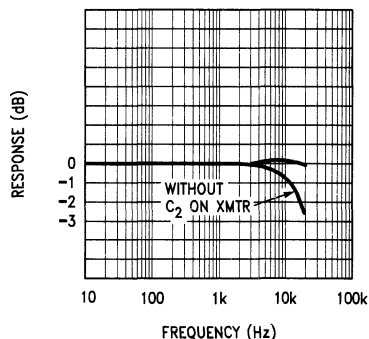
Adjustments are few and extremely simple. Transmitter carrier frequency f_c is fixed near 200 kHz by R_4 and C_4 ; the exact frequency is unimportant. T_1 for both transmitter and receiver are tuned for maximum coupling to and from the AC line. Plug in both receiver and transmitter; no carrier modulation is necessary. Insure that both units are operative. Observe or measure with an AC VTVM the waveform at T_1 secondary in the receiver. Tune T_1 of the transmitter for maximum observed signal amplitude. Then tune T_1 of the receiver for a further maximum. Repeat on the transmitter, then the receiver. Tuning is now complete for the line coupling transformers and should not have to be repeated for either. If the receiver is located some distance from the transmitter in use, or on the opposite side of the 110–220V service line, a re-adjustment of the receiver T_1 may be made to maximize rejection of SCR dimmer noise. The receiver PLL free-running frequency is adjusted by R_{16} . Set R_{16} near the center of its range. Rotate slowly in either direction until the PLL loses lock (evidenced by a sharp increase in noise and a distorted output). Note the position and then repeat, rotating in the other direction. Note the new position and then center R_{16} between the two noted positions. A fine adjustment may be made for minimum noise with an SCR dimmer in operation. The final adjustment is for modulation amplitude at the transmitter. Connect the audio signal to the transmitter input and adjust the input potentiometer R_1 for a signal maximum of about 0.1V rms at the input to the LM566. Adjustment is now complete for both transmitter and receiver and need not be repeated.

A STEREO SYSTEM

If full stereo or the two rear channels of a quadraphonic system are to be transmitted, both transmitter and receiver must be duplicated with differing carriers. Omit R_8 and include R_7 & C_2 on the transmitter if desired. Carriers could be set to 100 and 200 kHz for the two channels. Actually, they need only be set a distance of 40 kHz apart.

PERFORMANCE

Overall S/N is about 65 dB. Distortion is below about $\frac{1}{4}\%$ at low frequencies, and in actual program material it should not exceed $\frac{1}{2}\%$ as very little signal power occurs in music above about 1 kHz.



TL/H/7442-5

FIGURE 5. Overall System Performance
Transmitter Input to Input of Receiver Power Amplifier

The 2.5W audio amplifier provides an adequate sound level for casual listening. The LM380 has a fixed gain of 50. Therefore for a 2.5W max output, the input must be 89 mV. This is slightly less than the $\pm 10\%$ deviation level so we are within design requirements. Average program level would run a good 10 dB below this level at 28 mV input.

Noise rejection is more than adequate to suppress line noise due to fluorescent lamps and normal line transients. Appliance motors on the same side of the 110–220V line may produce some noise. Even SCR dimmers produce only a background of impulse noise depending upon the relative location of receiver and SCR. Otherwise, performance is noise-free anywhere in the home. Satisfactory operation was observed in a factory building so long as transmitter and receiver were connected to the same phase of the three-phase service line.

APPLICATIONS

Additional applications other than home music systems are possible. Intercoms are one possibility, with a separate transmitter and receiver located at each station. A microphone can serve as the source material and the system can act as a monitor for a nursery room. Background music may be added to existing buildings without the expense of running new wiring.

Low Cost IC Stereo Receiver

National Semiconductor
Application Note 147
Jim Sherwin



INTRODUCTION

The recent availability of a broad line of truly high-performance consumer integrated circuits makes it possible to construct a high quality, low noise, low distortion and low cost AM/FM/Stereo receiver. Design emphasis is placed on a high level of performance, minimum factory adjustments and low parts count. As such, the receiver has immediate applications to table-top, high-fidelity, automotive and communications markets.

Provisions are included for the addition of a ceramic phono unit as well as a tapehead amplifier allowing inclusion of eight-track or cassette transport systems. Complete tone control circuitry is provided offering both boost and cut of Bass and Treble frequencies. Left and right channel Balance, and system Volume complete the manual front-panel controls.

Panel meters are employed in the FM system for both signal strength and center tuning, allowing for easy and accurate tuning. A directly driven LED offers immediate indication of FM stereo reception.

The complete design requires just five IC's, restricting the use of discrete active elements to the preassembled FM front-end and the single transistor tone control design.

FM AND FM STEREO

A preassembled front-end was selected as the cost-effective approach to minimum parts count and minimum factory adjustments. This model features an FET input stage providing excellent distortion performance. High selectivity is obtained through the use of two cascaded ceramic filters yielding an approximate 6-pole response with less than 12 dB insertion loss.

The LM3089 FM IF System does all the major functions necessary for FM processing, including a three stage amplifier/limiter and balanced product detector, as well as an audio preamplifier. A single quadrature coil was used for ease of alignment; yielding recovered audio with THD less than 0.5%, however a double coil may be used to diminish THD to 0.1% if required. Carrier level detectors provide delayed AGC, SIGNAL strength meter drive, and adjustable interstation mute control R₁₁. The internal AFC amplifier was used to drive the TUNING meter, giving a visual indication of center tuning.

FM stereo demodulation is accomplished by the use of the LM1800 phase locked loop, thereby eliminating the need for external coils. Only two adjustments are necessary: R₁₄, which sets the 19 kHz oscillator, and R₁₇, which corrects

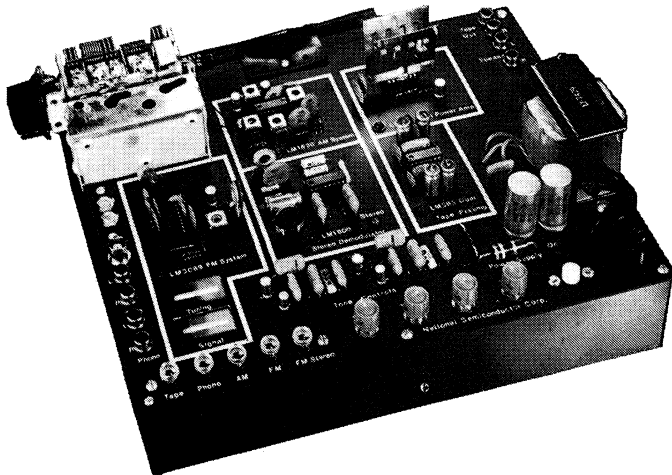


FIGURE 1. IC Receiver

TL/H/7250-1

which corrects for excess phase shift thru the IF stages, and yields maximum channel separation. Automatic stereo/monaural switching is built-in, and may be used in lieu of mechanical switching if desired. The open collector lamp driver is used to light a LED whenever a stereo station is encountered. (Further details available from application note AN-81.)

AM

The AM function of the receiver is done completely with the LM3820 AM radio system. While designed for 3 section tuned superheterodyne applications, the LM3820 may be used with the less expensive 2 section tuned designs by omitting the RF stage and redefining its function as 2ND IF stage (see linear brief LB-29). As shown, the LM3820 provides the necessary converter/oscillator, IF, and AGC detector functions, while the external diode D_1 does the audio demodulation. D_1 is slightly forward biased thru R_2 for improved distortion performance. In addition its resistance is used in conjunction with C_9 to form the first stage of the required low pass filter; the second stage consists of R_3 and C_{10} .

TAPE

The LM382 dual preamplifier was selected for its minimum parts count and low noise capability. With a guaranteed maximum equivalent input noise voltage of $1.2 \mu\text{V}_{\text{rms}}$ (10 kHz BW), it easily amplifies the low level tape signals while retaining excellent S/N ratio (~ 64 dB below 2 mV input level). An ion-implanted resistor matrix is supplied on the chip for self-biasing the output to half-supply, and provides the resistors necessary to create the NAB equalization curve; requiring only four external capacitors per channel to complete the amplifier. For production models this preamplifier would normally be mounted directly on the tape player to minimize hum and noise pick-up.

TONE CONTROLS

A single transistor tone control circuit was designed as the optimum cost/performance trade-off. The transistor is configured in a shunt-shunt feedback design, allowing gain variations between input functions. This is necessary to prevent sudden changes in output level when different inputs are selected. With a shunt feedback design the gain is easily controlled by choice of source impedance per *Figure 5*.

Approximately 20 dB of boost or cut of Bass and/or Treble frequencies is possible with the network shown. The turn-over frequencies are approximately 500 Hz and 1600 Hz for bass and treble, respectively. The insertion loss of approximately 27 dB is made up by the gain of the transistor tone

control amplifier. Balance and Volume controls are included as shown. Loudness control may be included by using a tapped Volume pot and the associated bass boost RC network if desired. More elaborate tone controls such as Bax-andall feedback are possible, but at a premium in cost.

POWER AMPLIFIER

The stereo power section, consisting of the LM378 dual audio amplifier, delivers 3W/channel with total harmonic distortion (THD) less than 1% and 4W/channel with THD less than 10%, operating from split supply voltages of $\pm 11\text{V}$. Split supplies were chosen to facilitate a minimum parts count design. This approach allows direct coupling of the amplifier to the speakers since the output DC level is zero volts (offset voltage will be less than 25 mV), thereby eliminating the need of large coupling capacitors and their associated degradation of power, distortion and cost. Since the input bias voltages are zero volts, the need for bias resistors and the bias-pin supply bypassing capacitor are also eliminated. Input capacitors are omitted and bias current for the positive input is obtained directly thru the Volume pots since the tone control circuitry has been designed such that there is no DC potential applied.

It is important to apply proper supply voltages and adequate heatsinking in using the LM2878. Note that while the standby and low output power operating points of the power supply are $\pm 15\text{V}$, the maximum power out point causes the supply to sag to $\pm 11\text{V}$ therefore reducing package dissipation to acceptable levels.

POWER SUPPLY

The worst case ripple rejection of 45 dB for the IC's used allows for a simple unregulated power supply, however the discrete front-end and tone control amplifiers require some regulation to preserve the IC performance. A single zener diode Z_1 was selected to create a +12V supply for this function. The split supplies required for the power amplifier are derived from a conventional full-wave bridge rectifier operating off of the center-tapped secondary of the line transformer.

REFERENCES

1. Isbell, T.D. and Mishler, D.S., "LM1800 Phase Locked Loop FM Stereo Demodulator". National Semiconductor Application Note AN-81, June 1973.
2. Papanicolaou, E.S. and Mortensen, H.H., "Low-Cost AM-Radio System Using LM1820 And LM386". National Semiconductor Linear Brief LB-29, May 1975.

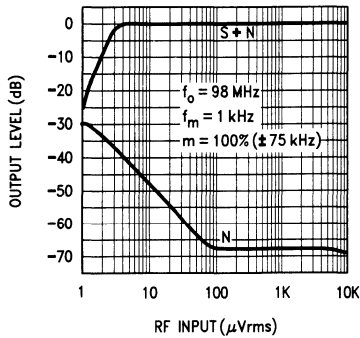


FIGURE 2. FM Sensitivity

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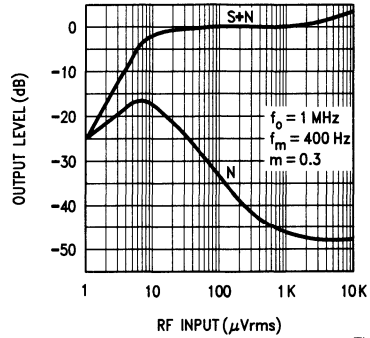


FIGURE 3. AM Sensitivity

TL/H/7250-3

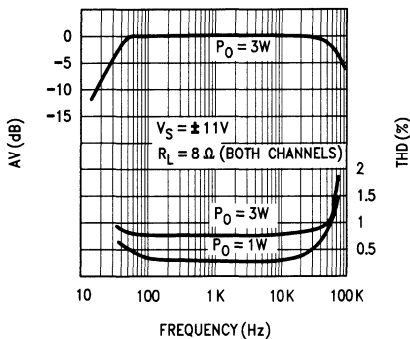
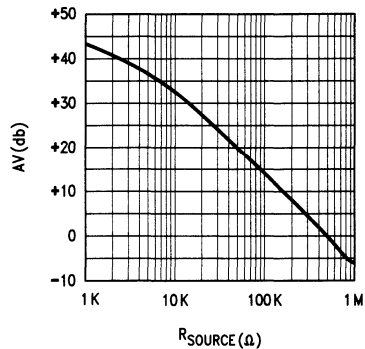


FIGURE 4. Power Amplifier Frequency Response and Total Harmonic Distortion

TL/H/7250-4

FIGURE 5. A_V vs. R_{SOURCE} for Tone Control Preamp State

TL/H/7250-5

SPECIFICATIONS

FM-MONO

- Sensitivity: $2.5 \mu\text{V}$ for 30 dB quieting
- Harmonic Distortion: 0.3%
- Hum * Noise: -65 dB
- Frequency Response: 50-15 kHz ± 3 dB

FM-STEREO

- Channel Separation: 45 dB
- Harmonic Distortion: 0.4%

AM

- Sensitivity: $20 \mu\text{V}$ for 20 dB S+N/N
- Harmonic Distortion: 2%
- Hum & Noise: -45 dB

TAPE

- Frequency Response: NAB equalized ± 2 dB
- Harmonic Distortion: 0.3%
- Hum & Noise: -64 dB below 2 mV input level

AMPLIFIER

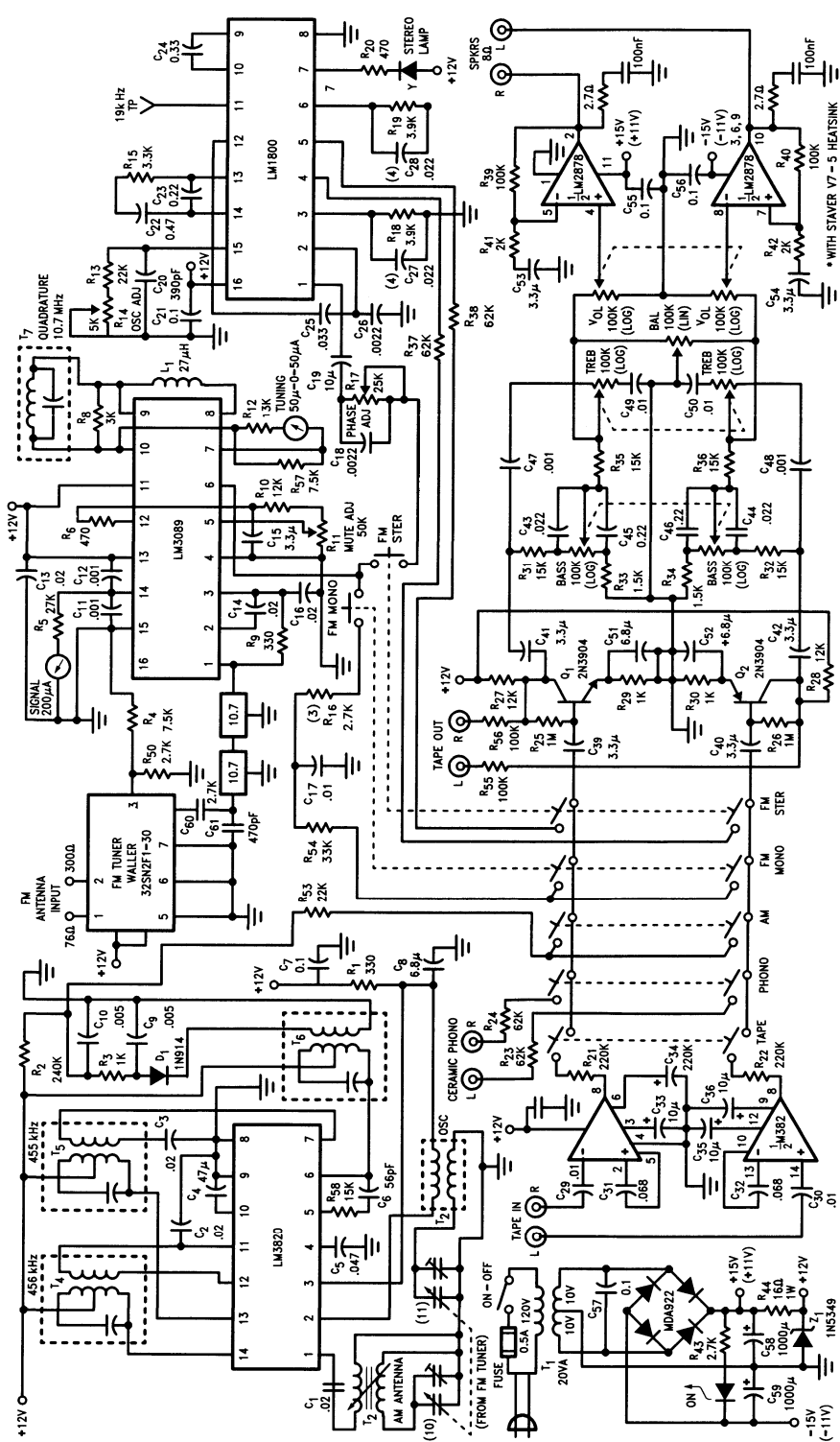
- Power Output: 3W RMS, per channel into 8Ω s at less than 1% THD from 40-30 kHz
- Frequency Response: 35-55 kHz ± 3 dbn

VENDOR DEVICES

- FM Tuner: Waller 32SN2F1-30
- Coils: T3: AM Osc. Toko RWO-6A6255
- T4: IF, 455 kHz Toko RRC-3A6426N
- T5: IF, 455 kHz Toko RRC-3A6427A
- T6: IF, 455 kHz Toko RZC-1A6425A
- T7: Quadrature, 10.7 MHz-Toko TKXC-33733BS
- Ceramic Filters: 10.7 MHz Toko CFS-30AE-10
- Selector Switch: IEE/Schadow Type F-4U with FA201 Mech. Reflecting Indicators
- Meters: TUNING: # 11226, SIGNAL: # 11222 Mercer Electronics

VENDOR LOCATIONS

- Waller Corp., Crystal Lake, ILL. (815) 459-6510
- Toko (America), Inc. Toko America, Inc. 1250 Feehanville Drive Mount Prospect, IL 60056 Tel: (312) 297-0070
- IEE/Schadow Corp., Eden Prairie Minn. (612) 944-1820
- Mercer Electronics (Simpson Electric Co.), Elgin, ILL. (312) 379-1130



TLH/7250-6

FIGURE 6. Complete Schematic

- Note 1: All unmarked resistors in Ω s, 1/4W.
- Note 2: All unmarked capacitors in microfarads.
- Note 3: Omit for 50 μ s de-emphasis.
- Note 4: Change to 0.015 μ F for 50 μ s de-emphasis.

1.3V IC Flasher, Oscillator, Trigger or Alarm

National Semiconductor
Application Note 154



INTRODUCTION

Most linear integrated circuits are designed to operate with power supplies of 4.5 to 40V. Practically no battery/portable equipment is provided with indicator lights due to unacceptable power drain. Even LEDs (solid state lamps) won't light from a 1.5V battery, and drain the common 9V radio battery in a few hours.

The LM3909 changes all this. Obtaining long life from a single 1.5V cell, it opens a whole new area of applications for linear integrated circuits. Sufficient voltage for flashing a light emitting diode is generated with cell voltage down to 1.1V. In such low duty cycle applications batteries will last for months to years of continuous operation. Such flasher circuits then become practical for marking location of flashlights, emergency equipment, and boat mooring floats in the dark.

The LM3909 is simple in design, easy to use, and includes extra resistors to minimize external circuitry and the size of the completed flasher or oscillator.

CIRCUIT OPERATION

The circuit below in *Figure A* is the LM3909 connected as the simplest type of oscillator. Ignoring the capacitor for a moment, and assuming 1.5V on pin 5, current will flow in the

3k and 6k timing resistors through the emitter of Q_1 . This current will be amplified by about 3 by Q_2 and passed to the base of Q_3 . Q_3 will then conduct, pulling down on the base of Q_4 and hence the base of Q_1 . This is a negative feedback since it will reduce timing resistor current and current to the power transistor's base until a balance is reached. This will occur with the collector of Q_3 at about 0.5V, the base of Q_4 at about 1V, and a very small voltage from pin 8 to ground. The difference between these two voltages is the base-emitter drop of Q_1 and $2/3$ the base-emitter drop of Q_4 as set by the high resistance divider from its base to emitter.

Note that negative feedback *voltage* is attenuated by at least 2 due to the divider of two 400 Ω resistors. Now considering the capacitor, its positive feedback is initially unity. Therefore the DC bias condition and the temporary excess positive feedback conditions are met and the circuit must oscillate.

The waveform at pin 8 of the above oscillator is shown below. The waveform at pin 2, the power transistor collector, is almost a rectangle. It extends from a saturation voltage of 0.1V or less to within about 0.1V of the supply voltage. The "on" period of course coincides with the negative pulses at pin 8. Other circuit voltages can easily be inferred from the two waveforms in *Figure B*.

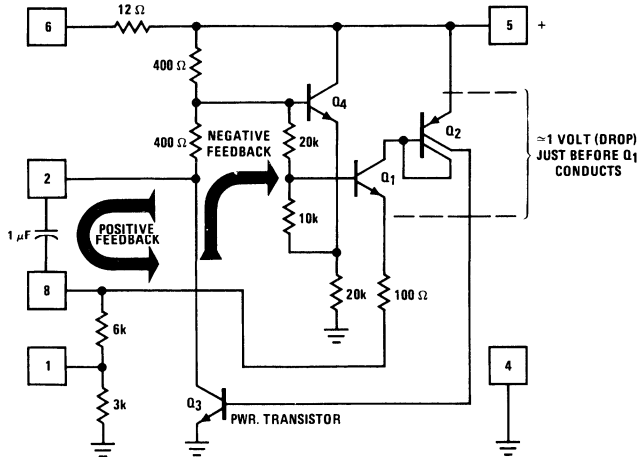


FIGURE A

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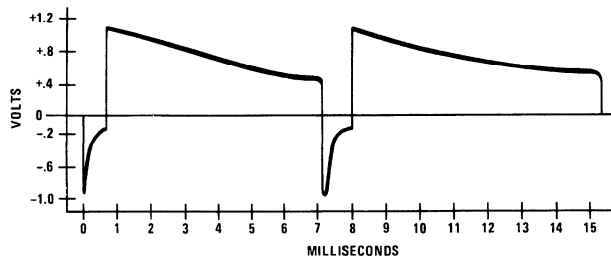


FIGURE B

TL/C/7213-2

The simplicity of LED and incandescent pilot lamp flashers is illustrated below in *Figure 1*. In the LED flasher, the LM3909 uses the single capacitor for both timing and voltage boosting.

The LM3909, although designed as a LED flasher, is ideal for other applications such as high current, trigger pulse for SCRs and "Triacs." The frequency of oscillation adjusts from under 1 Hz to hundreds of kHz. Wave shape can be set from pulses a few μs wide to approximately a square wave. Thus the LM3909 can perform as a sound effects generator, an audible alarm, or audible continuity checker. Finally it can be a radio (detector/amplifier), low power one-way intercom, two-way telegraph set, or part of a "mini-strobe" light flashing up to 7 times per second.

Operating with only a 1.5V battery as a supply gives the LM3909 several rather unique characteristics. First, *no* known connection can cause immediate destruction of the IC. Its internal feedback loop insures self-starting of properly loaded oscillator circuits. Experimenters can safely explore the possibilities of the LM3909 as an AC amplifier, one-shot, latch circuit, resistance limit detector, multi-tone oscillator, heat detector, or high frequency oscillator.

With the accent on the practical, a brief circuit description will be given followed by circuits in the following application areas:

- Flasher & Indicator Applications
- Audio & Oscillator Applications
- Trigger & Other Applications

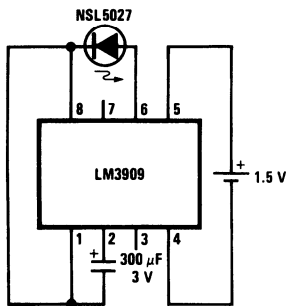
For those who want to modify or design their own circuits using the LM3909, application hints will be covered near the end of this note.

CIRCUIT DESCRIPTION

The circuit of *Figure 2* again shows the typical 1.5V LED flasher, but with the internal circuitry of the IC illustrated.

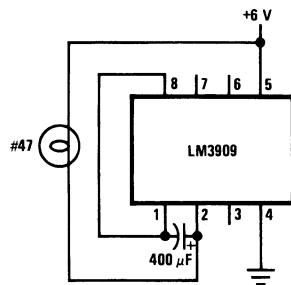
The flasher achieves minimum power usage in two ways. Operated as above, the LED receives current only about 1% of the time. The rest of the time, all transistors but Q₄ are off. The 20k resistor from Q₄'s emitter to supply-common draws only about 50 μA . The 300 μF capacitor is charged through the two 400 Ω resistors connected to pin 5 and through the 3k resistor connected to pin 4 of the circuit.

1.5V Flasher



Note: Nominal Flash Rate: 1 Hz.

Incandescent Bulb Flasher



TL/C/7213-3

Note: Flash Rate: 1.5 Hz.

FIGURE 1. Two Simple Flashers

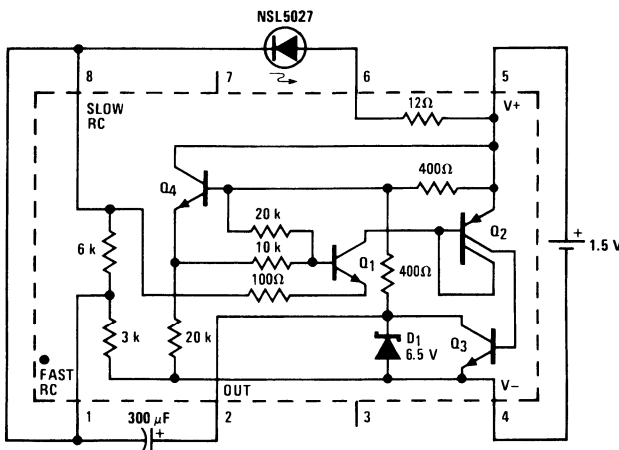


FIGURE 2. Circuit Operation

TL/C/7213-4

Transistors Q₁ through Q₃ remain off until the capacitor becomes charged to about 1V. This voltage is determined by the junction drop of Q₄, its base-emitter voltage divider, and the junction drop of Q₁. When voltage at pin 1 becomes a volt more negative than that at pin 5 (supply positive terminal) Q₁ begins to conduct. This then turns on Q₂ and Q₃.

The LM3909 then supplies a pulse of high current to the LED. Current amplification of Q₂ and Q₃ is between 200 and 1000. Q₃ can handle over 100 mA and rapidly pulls pin 2 close to supply common (pin 4). Since the capacitor is charged, its other terminal at pin 1 goes below the supply common. The voltage at the LED is then higher than battery voltage, and the 12Ω resistor between pins 5 and 6 limits the LED current.

Many of the other oscillator circuits work in a similar fashion. If voltage boost is not needed (with or without current limiting) loads can be hooked between pins 2 and 6 or pins 2 and 5.

APPLICATIONS: FLASHER & INDICATOR

Differing uses and supply voltages will require adjustment of flashing rates. Often it is convenient to leave the capacitor the same value to minimize its size, or to fix the pulse energy to the LED. First, the internal RC resistors can be used to obtain 3k, 6k, or 9k by hooking to or shorting the appropriate pins. Further adjustment methods are shown in the two parts of Figure 3 below.

In Figure 3a, it can be seen that the internal RC resistors are shunted by an external 1k between pins 8 and 4. This will give a little over 3 times the flashing rate of the typical 1.5V flasher of Figure 1.

The 3.9k resistor in Figure 3b connected from pin 1 to the 6V supply raises voltage at the bottom of the 6k RC resistor. Charging current through that resistor is greatly reduced, bringing flashing rate down to about that of the 1.5V circuit (1 Hz). As will be explained later, this biasing method also insures starting of oscillation even under unfavorable conditions.

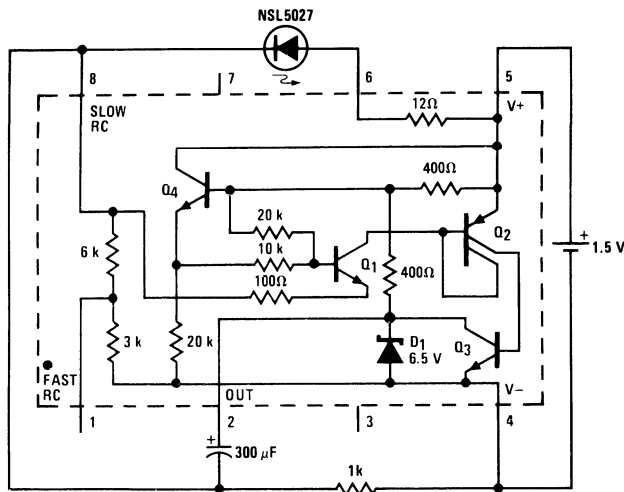


FIGURE 3a. Fast Blinker

TL/C/7213-5

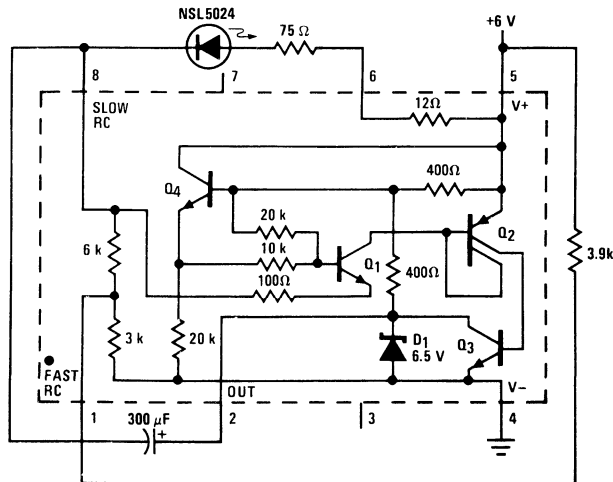


FIGURE 3b. 6 Volt Flasher

TL/C/7213-6

Two precautions are taken for circuit reliability. The added 75Ω series resistor for the LED keeps current peaks within safe limits for the diode and IC. Also, in operation above a 3V supply, the electrolytic capacitor sees momentary voltage reversals. It should be rated for periodic reversals of 1.5V.

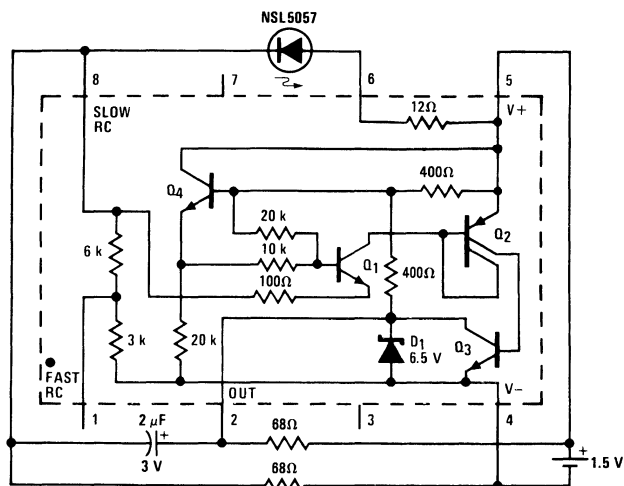
A continuously appearing indicator light can also be powered from a single 1.5V cell as shown in *Figure 4*. Duty cycle and frequency of the current pulses to the LED are increased until the average energy supplied provides sufficient light. At frequencies above 2 kHz, even the fastest movement of the light source or the observer's head will not produce significant flicker.

Since this indicator powering circuit uses the smallest capacitor that will reliably provide full output voltage, its operating frequency is well above the 2 kHz point. The indicator is not, however, intended as a long life system, since battery drain is about 12 mA.

High frequency operation requires addition of *two* external resistors, typically of the same value. One, of course, shunts the high internal timing resistors. If only this one were used, the capacitor charging current would have to pass through the two 400Ω resistors internally connected between pin 5 and the collector of Q3. Oscillation at a slower rate and lower duty cycle than desired would occur, and oscillation might cease altogether before the battery was fully discharged. The second 68Ω resistor shunting the two 400Ω resistors eliminates these problems.

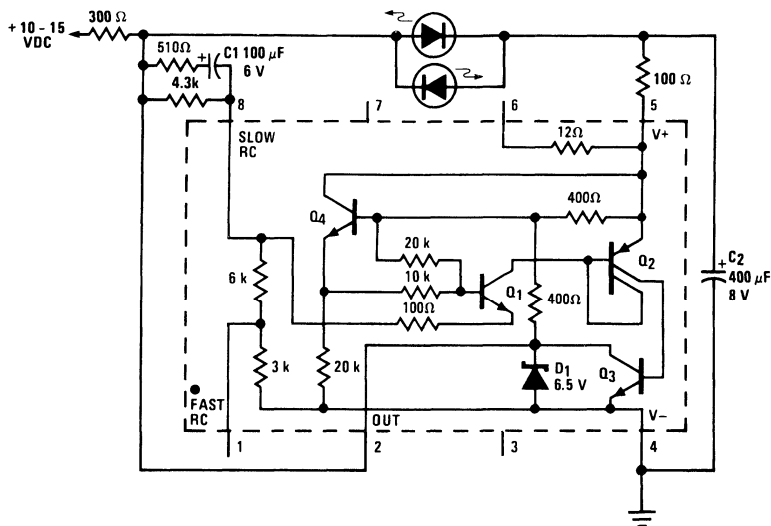
The circuit in *Figure 5* is a relaxation type oscillator flashing 2 LEDs sequentially. With a 12 VDC supply, repetition rate is 2.5 Hz. C_2 , the timing and storage capacitor, alternately charges through the upper LED and is discharged through the other by the IC's power transistor, Q3.

If a red/green flasher is desired, the green LED should have its anode or plus lead toward pin 5 (like the lower LED). A shorter but higher voltage pulse is available in this position.



TL/C/7213-7

FIGURE 4. "Continuous" 1.5V Indicator



TL/C/7213-8

FIGURE 5. Alternating Flasher

Indication or monitoring of a high voltage power supply at a remote location can be done much more safely than with neon lamps. If the dropping resistor (43k as in *Figure 6*) is located at the source end, all other voltages on the line, the IC, and the LED will be limited to less than 7V, above ground.

The timing capacitor is charged through the dropping resistor and the two 400Ω collector loads between pins 2 and 5 of the IC. When capacitor voltage reaches about 5V, there is enough voltage across the 1k resistor (to pin 8) to turn on Q₁, and hence trigger on the whole IC to discharge the capacitor through the LED.

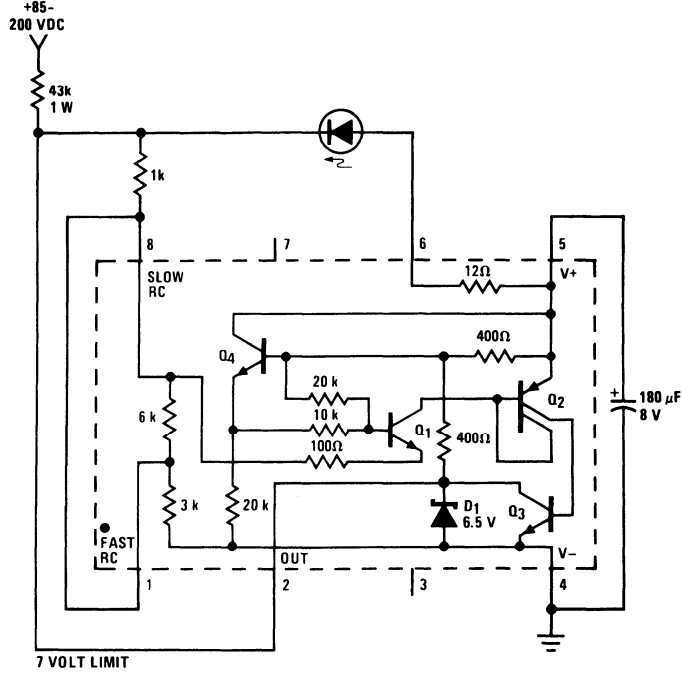


FIGURE 6. Safe, High Voltage Flasher

TL/C/7213-9

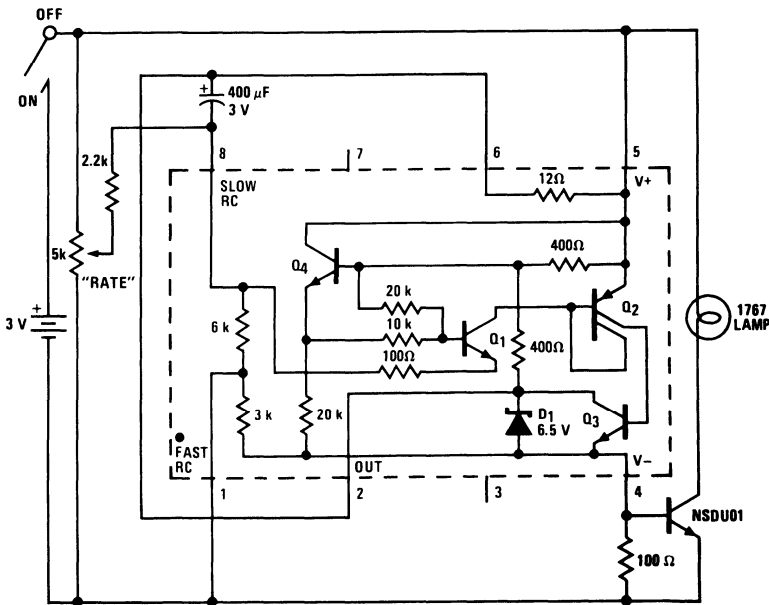


FIGURE 7. "Mini-Strobe" Variable Flasher

TL/C/7213-10

There are many other LED applications and variations of circuits. A chart outlining operation of the circuit of *Figure 6* at various voltages appears on the LM3909 data sheet. Also shown are circuits for adjusting the flash rate, flashing 4 LEDs in parallel, and details for building a blinking locator light into an ordinary flashlight.

Incandescent bulbs can also be flashed, as already illustrated in *Figure 7*. However, most such bulbs draw more than the 150 mA that the LM3909 can switch. The two following circuits therefore use an added power transistor rated at 1A or more. In each circuit, an NPN transistor is used, so the power transistor's base drive is obtained from the common or ground pin of the flasher IC.

The 3V "mini-strobe" of *Figure 7* may be used as a variable rate warning light or for advertising or special effects. The rate control is so wide range that it adjusts from no flashes at all to continuously on. Chosen for rapid response, the miniature 1767 lamp can be flashed several times a second.

A "mini-strobe" circuit was tested in a Lantern Flashlight with a large reflector. In a dark room, the flashes were almost fast enough to stop a person's motion. As a toy, the fast setting can mimic the strobes at rock concerts or the flicker of old-time movies.

Figure 8 below shows a higher power application such as would use an automotive storage battery for power. It provides about a 1 Hz flash rate and powers a lamp drawing a nominal 600 mA.

A particular advantage of this circuit is that it has only 2 external wires and thus may be hooked up in either of the two ways shown below in *Figure 9*. Further, no circuit failure can cause a battery drain greater than that of the bulb itself, continuously lit.

In the circuit of *Figure 8*, the 3300 μF capacitor performs a number of other functions. It makes the LM3909 immune to supply spikes, and provides the means of limiting the IC's supply voltage. Since the LM3909 can only operate with

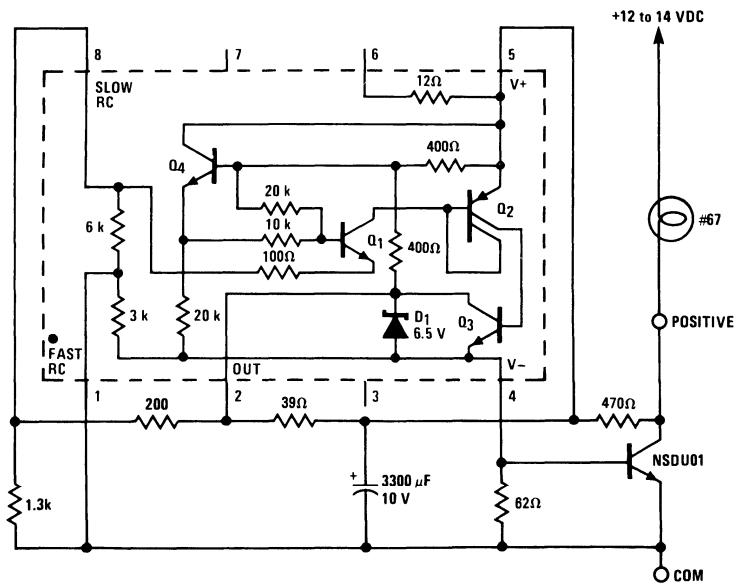
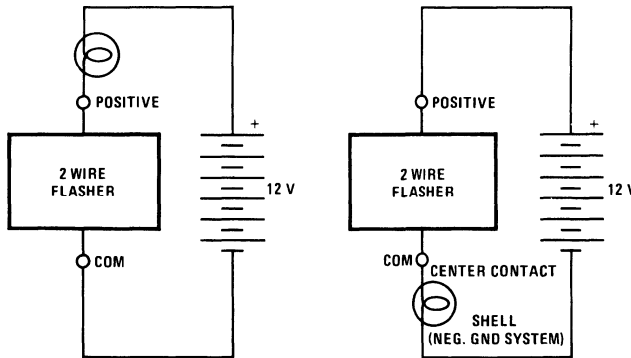


FIGURE 8. 12 Volt Flasher (2 Wire)

TL/C/7213-11



Note: If flasher case insulated, it will operate in positive or negative ground systems.

FIGURE 9. 2 Wire Flasher Usage

TL/C/7213-12

7.5V or less on pin 5 (in this circuit) the 200 Ω /1.3k divider attached to pin 8 of the IC causes it to turn fully on at 7V or less on pin 5. Then the LM3909 discharges the timing capacitor (its own supply voltage) to 4V or less, whereupon it turns off. The capacitor discharge current comes out of pin 4 of the IC, turning on the NSD U01 transistor. It is the large size of the timing capacitor that allows it to store all the needed energy for turning on the power transistor. This in turn permits the whole flasher circuit to operate as a 2 wire device.

Many other flasher possibilities exist. LED flash rate can be varied from 0 to 20 Hz, or a number of LEDs may be flashed in parallel. With a 3V supply, yellow and green LEDs may be flashed. A 6V incandescent "emergency lantern" can be made and its PR-13 bulb may be made to give continuous light or flash by switch selection. This is a more reliable, longer lived system than a lantern with a second thermal flasher bulb. The NSL4944 Current Regulated LED makes possible flashing many LEDs in parallel or with high voltages without series resistors.

APPLICATIONS: Audio & Oscillator

Very economical continuity checkers, tone generators, and alarms may be made from the LM3909. No matching transformer is needed because the 150 mA capability of the LM3909 output can drive many standard permanent magnet (transistor radio) loudspeakers directly. The 1.5V battery used in most applications is both lower in cost and longer lasting than the conventional 9V battery.

In the continuity checker of *Figure 10*, a short, up to about 100 Ω , across the test probes provides enough power for audible oscillation. By probing 2 values in quick succession, small differences such as between a short and 5 Ω can be detected by differences in tone.

A novel use of this circuit is found in setting the timing of certain types of motorcycles. This is due to the difference in tone that can be heard from the tester depending whether there is a short or not across the low resistance primary of the 'cycle's ignition coil. In other words, the difference be-

tween a 1 Ω resistor and a 1 Ω inductor can be heard. Quick checks for shorts and opens in transformers and motors can therefore be made.

Darkrooms, laundry rooms, laboratories, and cellar workshops can often suffer damage from spills or water seepage ruining lumber, chemicals, fertilizer, bags of dry concrete, etc. The circuit of *Figure 11* is safe on potentially damp floors since there is no connection to the power line. Further, its standby battery drain of 100 μ A yields a battery life close to (or, according to some experiments, exceeding) shelf life.

Without moisture, multivibrator transistor Q_a is completely off, and its collector load (6.2k) provides enough current to hold pin 8 of the LM3909 above 0.75V where it cannot oscillate. When the sense electrodes pass about 0.25 μ A, due to moisture, Q_a starts turning on, and since Q_b is already partially biased on, positive feedback now occurs. Q_a and Q_b are now an astable multivibrator which starts at about 1 Hz and oscillates faster as more leakage passes across the sense electrodes.

This "multi" then acts as both an amplifier and a modulator. The pulse waveform at the collector of Q_a varies the timing current through the 3.9k resistor to pin 8 of the LM3909 resulting in a distinctively modulated tone output.

The sensor should be part of the base of the box the alarm circuitry is packaged in. It consists of two electrodes six or eight inches long spaced about $\frac{1}{8}$ inch apart. Two strips of stainless steel on insulators, or the appropriate zig-zag path cut in the copper cladding of a circuit board will work well. The bare circuit board between the copper sensing areas should be coated with warm wax so that moisture on the floor, *not* that absorbed by the board, will be detected. The circuit and sensor can be tested by just touching a damp finger to the electrode gap.

Minimum cost, simplicity, and very low power drain are the aims of the Morse Code set of *Figure 12*. One oscillator simultaneously drives speakers at both sending and receiv-

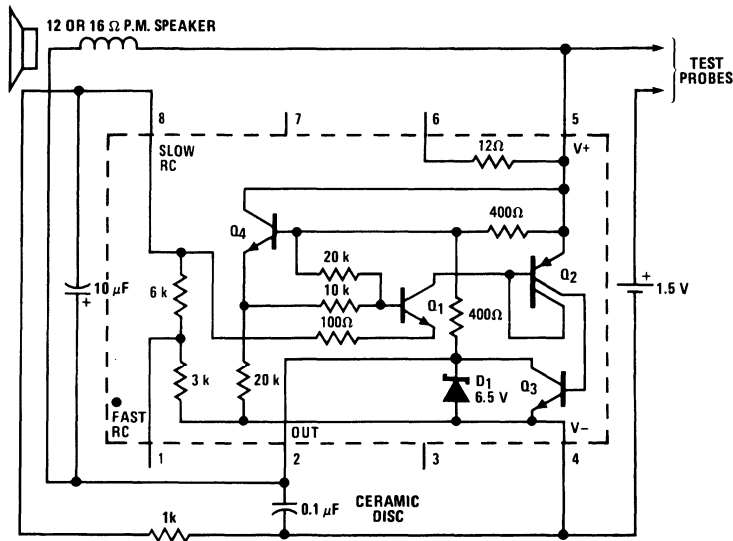


FIGURE 10. "Buzz Box" Continuity and Coil Checker

TL/C/7213-13

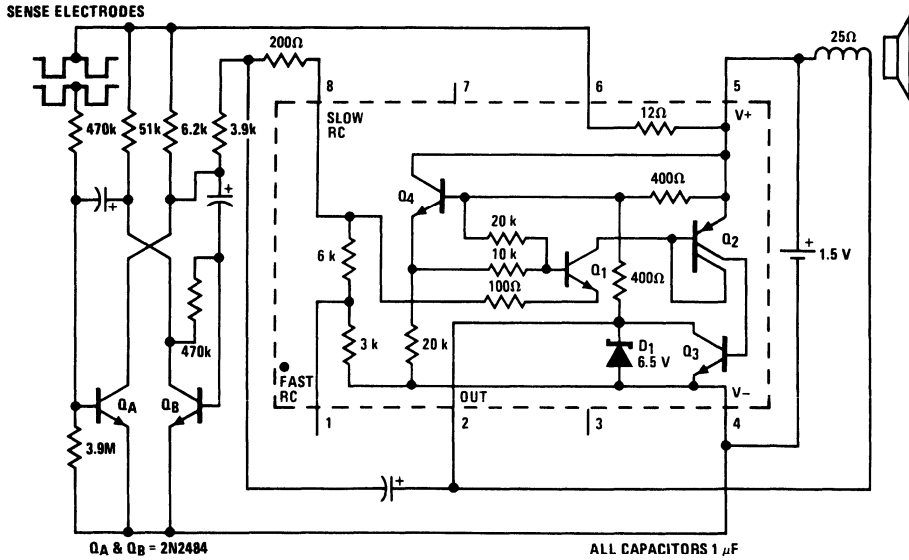


FIGURE 11. Water Seepage Alarm

TL/C/7213-14

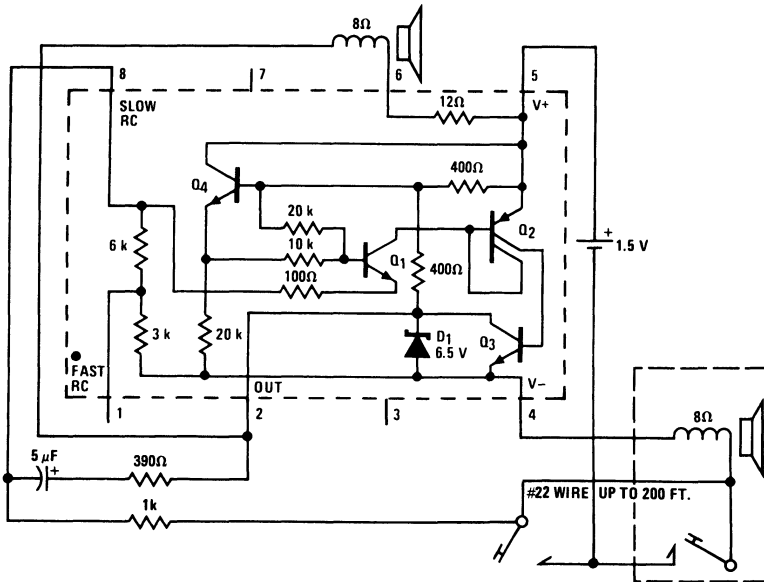


FIGURE 12. Morse Code Set

TL/C/7213-15

ing ends. Calculations and actual use tests indicate life of a single alkaline penlight cell to be 3 months to over a year depending on usage. "Buzzer" type sets use two or more batteries with much shorter life.

Commonly available, low cost 8 Ω speakers are effectively in series to better match LM3909 characteristics. The three wire system and parallel telegraph keys allow beginners and children to use the set without having to understand use of a "send-receive" switch.

The two resistors are added to obtain a suitable average power output and electrically force the oscillator toward the desired 50% duty cycle. Acoustically, both speakers are operated at resonance (about 400 Hz in the prototype) for maximum pleasing tone with minimum power drain. Each of the two speaker enclosures has holes added to augment this resonance. For each different type or brand of speaker and size of box, hole and capacitor sizes will have to be determined by experiment for the most stable resonant tone over the expected battery voltage variation.

Experiments with the above circuit led to development of circuit in Figure 13. It is optimized to oscillate at any *acoustic* load frequency of resonance! With just a speaker, oscillation occurs at the speaker cone "free-air" resonance. If the speaker is in an enclosure with a higher resonant frequency ... this becomes the frequency at which the circuit oscillates.

An educational audio demonstration device, or simply an enjoyable toy, has been fabricated as follows. A roughly cubical box of about 64 in.³ was made with one end able to

slide in and out like a piston. The box was stiffened with thin layers of pressed wood, etc. Minimum volume with the piston in was about 10 in.³. Speaker, circuit, battery, and all were mounted on the sliding end with the speaker facing out through a 2 $\frac{1}{4}$ in. hole. A tube was provided (2 $\frac{1}{2}$ in. long, $\frac{5}{16}$ in. ID) to bleed air in and out as the piston was moved while not affecting resonant frequency.

"Slide tones" can be generated, or a tune can be played by properly positioning the piston part and working the push button. Position and direction of the piston are rather intuitive, so it is not difficult to play a reasonable semblance of a tune after a few tries.

The 12 Ω resistor in series with pin 2 (output transistor Q₃'s collector) and the speaker, decouples voltages generated by the resonating speaker system from the low impedance switching action of Q₃. The 100 μ F feedback capacitor would normally set a low or even sub-audio oscillation frequency. Therefore, the major positive feedback voltage to pin 8 is the resonant motion *generated* voltage from the speaker voice coil. Therefore the LM3909 will continue to drive the speaker at the resonance with the highest combined amplitude and frequency.

It can be seen already that the LM3909, having direct speaker drive and resonance following capability, can do things that are a lot less practical with older timer and unijunction circuitry. Two final "sound effect" type of circuits are illustrated in Figure 14.

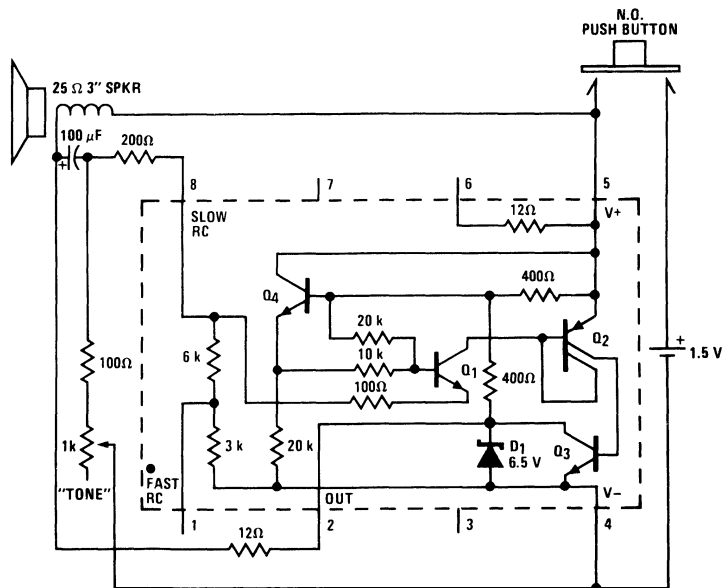


FIGURE 13. Electronic "Trombone"

TL/C/7213-16

The siren of *Figure 14a* produces a rapidly rising wail upon pressing the button, and a slower "coasting down" upon release. If it is desirable to have the tone stop sometime after the button is released, an 18k resistor may be placed between pins 8 and 6 of the IC. The sound is then much like that of a motor driven siren.

In this circuit, the oscillation must not be influenced by acoustic resonances. The 1 μF capacitor and 200 Ω resistor determine a pulse to the speaker that is wider than that for flashing LEDs, but much narrower than is used in the tuned systems of *Figures 12* and *13*. The repetition rate of speaker pulses is determined by the 2.7k resistor, and the charge on the 500 μF capacitor. Discharging this capacitor with

the pushbutton increases current in the 2.7k resistor causing a rapid upshift in tone.

The "whooper" of *Figure 14b* sounds somewhat like the electronic sirens used on city police cars, ambulances, and airport "crash wagons." The rapid modulation makes the tone seem louder for the same amount of power input.

The tone generator is the same as in the previous siren. Instead of a pushbutton, a rapidly rising and falling modulating voltage is generated by a second LM3909 and its associated 400 μF capacitor. The 2N1304 transistor is used as a low voltage (germanium) diode. This transistor along with the large feedback resistor (5.1k to pin 8) forces the ramp generator LM3909 into an unusual mode of operation hav-

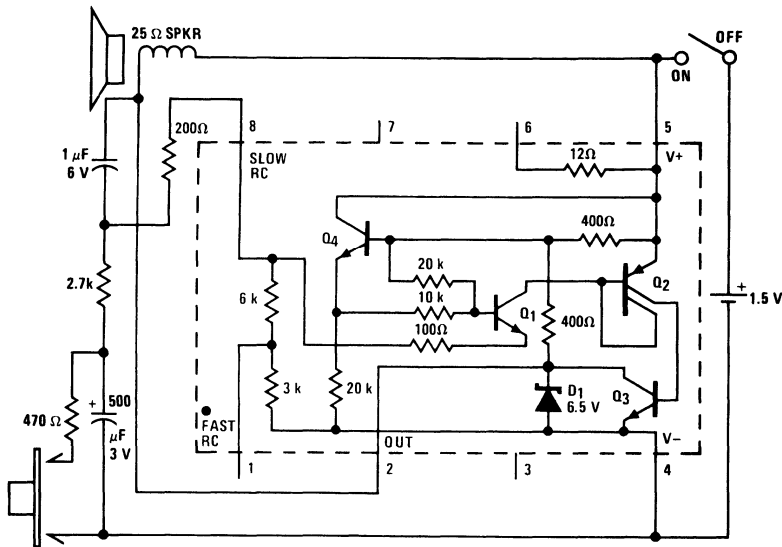


FIGURE 14a. Fire Siren

TL/C/7213-17

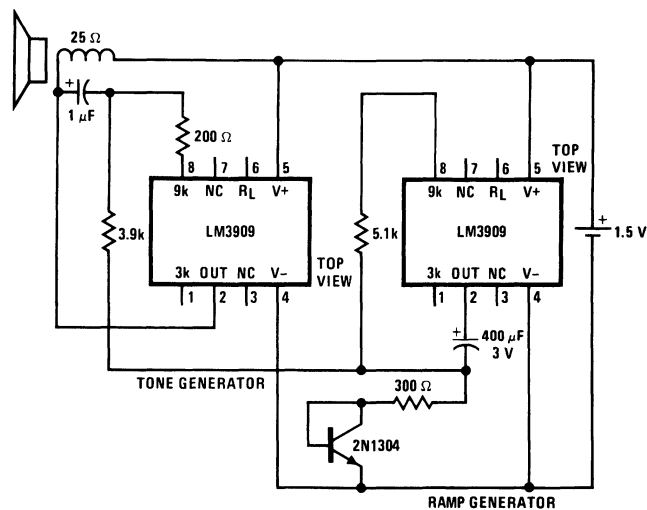


FIGURE 14b. Whooper Siren

TL/C/7213-18

ing longer "on" periods than "off" periods. This raises the average tone of the tone generator and makes the modulations seem more even.

APPLICATIONS: Trigger & Other

With its high pulse current capability, the LM3909 is a good pulse-transformer driver. Further, it uses fewer parts and operates more successfully from low voltage supplies than do the equivalent unijunction circuits. The "Triac" trigger of *Figure 15* operates from a 5V logic supply and provides gate trigger pulses of up to 200 mA.

With no gate input, or a TTL logic high input, the LM3909 is biased off since pin 1 is tied to V+. With a logic low at the gate in, the IC provides 10 μ s pulses at about a 7 kC rate. A TTL gate loaded only by this circuit is assumed since otherwise worst-case voltage swing may be insufficient. This trigger is not of the "Synchronized Zero Crossing" type since the first trigger pulse after gating on could occur at any time. However, the repetition rate is such that after the first cycle, a triac is triggered within 8V of zero with a resistive load and a 115 VAC line.

The standard Sprague PC mounting transformer provides a 2:1 current step-up, and suitable isolation between the low voltage circuitry and power lines up to 240 VAC. Resistor R_g, which includes transformer winding resistance, can be as little as 3 or 4 Ω for high current triacs. Low current types may need excessive "holding" current with such low R_g, so it may be raised to as much as 100 Ω with a sensitive gate triac.

Oscillation of the LM3909 will start when the DC bias at pin 8 is between 1.6 and 3.9V. In *Figure 15*, pin 8 is connected between the 10k input resistor and a 6k resistor to 5V. With 3.8V in, pin 8 is at 4.5V so there is no oscillation. With 1V, or less, in, pin 8 is at 3.5V or below and oscillation

occurs. From this example, it can be seen that other input resistors or bias dividers can be calculated to gate the LM3909 triac trigger from other logic levels.

A useful electronic lab device is a precision square wave generator/calibrator. If the output is held at a few tenths percent of 1V, peak-to-peak, it is useful in calibrating oscilloscopes and adjusting 'scope probes. Many lower cost or battery-portable oscilloscopes do not have this feature built in. Also it is useful in checking gain and transient response of various amplifiers including "hi-fi" power amplifiers.

Battery powered equipment is free from both the inconvenience of a line cord, and from some of the noise and hum effects of equipment attached to the power line. Operation for over five hundred hours from a single flashlight "D" cell is the bonus provided by the circuit of *Figure 16*. The lowest reference voltage regulator available, the LM113, is used in conjunction with a current source, and the voltage boost characteristic of the LM3909.

Output is a clean rectangular wave which can be adjusted to exactly a 1V amplitude. A rectangular wave of approximately 1.5 ms "on" and 5.5 ms "off" was chosen for circuit simplicity and low battery drain. Waveform clipping is virtually flat due to complete turn-off of the current switch Q₂ and the typical "on" impedance of 0.2 Ω provided by the LM113. The 0.01% temperature coefficient of the LM113 at room temperature allows negligible drift of the waveform amplitude under laboratory conditions. Loading by a 'scope probe will also be insignificant.

The circuit will work properly down to battery voltages of 1.2V. This is because the 100 μ F electrolytic capacitor drives the emitter of Q₂ below the supply minus terminal. At a battery voltage of 1.2V, the collector of Q₂ can still swing more than 1.6V. Q₁ uses the "off" periods of the LM3909 to insure that the 100 μ F capacitor is charged to almost the

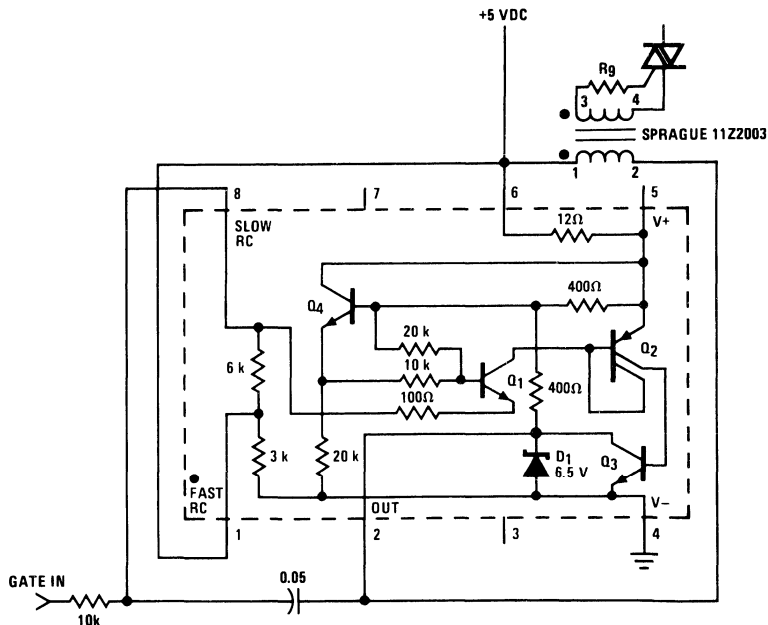


FIGURE 15. Triac Trigger

TL/C/7213-19

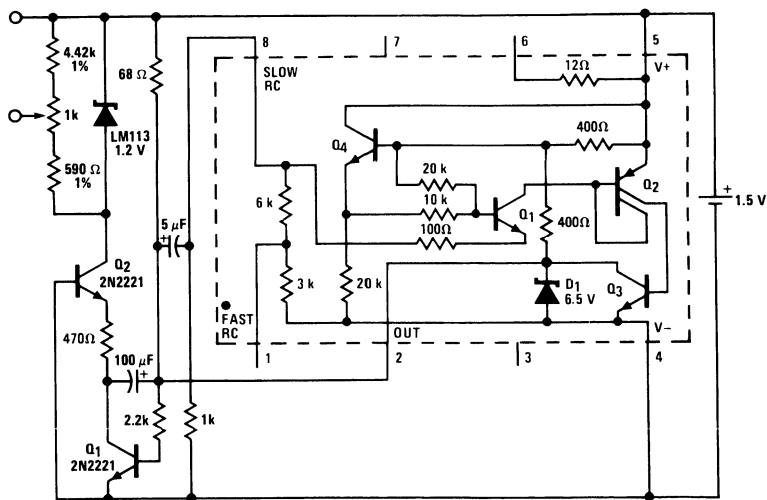


FIGURE 16. 'Scope Calibrator

TL/C/7213-20

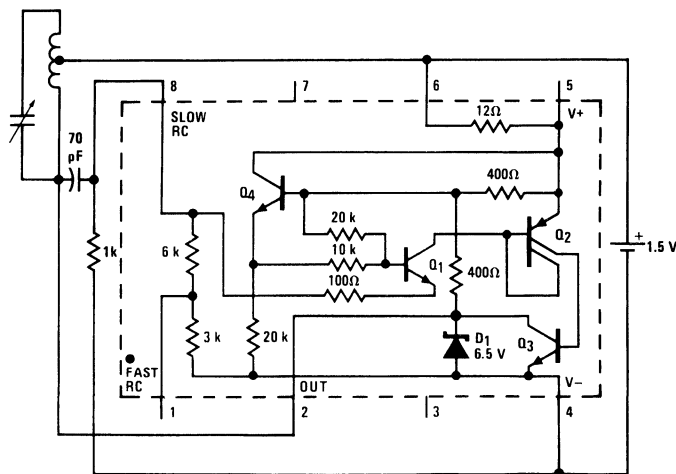


FIGURE 17. R.F. Oscillator

TL/C/7213-21

entire battery voltage. Thus when the LM3909 turns on and pin 2 drives almost to the minus supply voltage, the negative side of the capacitor is driven 0.9 to 1.2V below this terminal. Low battery voltage cannot lead to an undetected error in the 1V squarewave. This is because the waveform becomes distorted rather than just decreasing in amplitude as battery voltage becomes too low.

Taking advantage of the versatility and the indestructibility of the LM3909 by a 1.5V battery, the IC can become an ideal teaching means, or experimental device for the young electronic hobbyist. As well as the circuits already presented, the LM3909 can be made to work as amplifier, radio, and even logic type circuits. The ideas of negative and positive feedback can be presented. The circuits presented in Figures 17 through 21 are intended as illustrations or demonstrations of circuitry concepts such as would be used in an experimenter's kit. They are not meant to be used as parts of finished commercial products with specific perform-

ance specifications. In other words, working circuits have been breadboarded, but no measurements of performance such as frequency range and distortion have been attempted.

Both tuned circuits of Figures 17 and 18 use standard AM radio ferrite antenna coils (loopsticks) with a tap 40% of the turns up from one end. The oscillator works up to 800 kHz or so, and the radio tunes the regular AM broadcast band. Both also use standard (360 pF) AM radio tuning capacitors.

The oscillator has the normal capacitive positive feedback used with LM3909 circuits, but with frequency determined by the tuned circuit loading the output circuit. Detailed operating descriptions of these experimenter's circuits will not be attempted in order to keep down the length of this note. Near the end, a discussion of the IC's general theory of operation will be given, which should help in understanding the individual circuits.

In the radio circuit of *Figure 18*, the LM3909 acts as a detector amplifier. It does not oscillate because there is no positive feedback path from pin 2 to pin 8. The tuning ability is only as good as simple "crystal set," but a local radio station can provide listenable volume with an efficient 6 inch loudspeaker. Extremely low power drain allows a month of continuous radio operation from a single "D" flashlight cell.

Antennae for the radio circuit can be short (10 to 20 feet) and connected directly to the end of the antenna coil as illustrated. Longer antennae (30 to 100 feet) work better if attached to the previously mentioned tap on the coil . . . also illustrated.

The following two circuits are examples of logic or computer type functions. They use 3V power supplies (2 cells) because the LM3909 was designed not to have any stable or "latching" states with a 1.5V supply.

Switches on both the above circuits are momentary types. In each case a small charge or impulse affects the circuit's state. The circuit of *Figure 19* switches to and holds its condition whenever the switch changes sides, even if contact is made only very briefly. The circuit of *Figure 20* delivers about a 1/2 second flash from the LED every time its push-button makes contact, whether briefly or for a much longer period of time. Such circuits are used with keyboards, limit switches, and other mechanical contacts that must feed data into electronic digital systems.

By again leaving out the positive feedback capacitor, the LM3909 can become a low power amplifier. This little audio amplifier can be used as a one-way intercom or for "listening in" on various situations. Operating current is only 12 to 15 mA. It can hear fairly faint sounds, and someone speaking directly into the microphone generates a full 1.4V peak-to-peak at the loudspeaker.

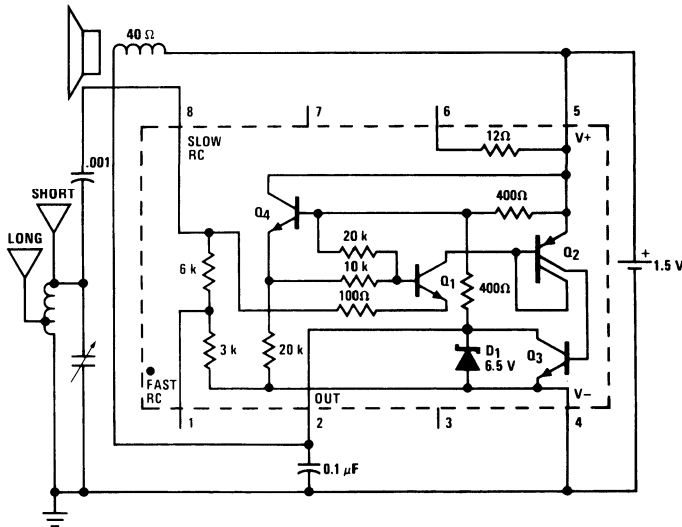


FIGURE 18. Radio

TL/C/7213-22

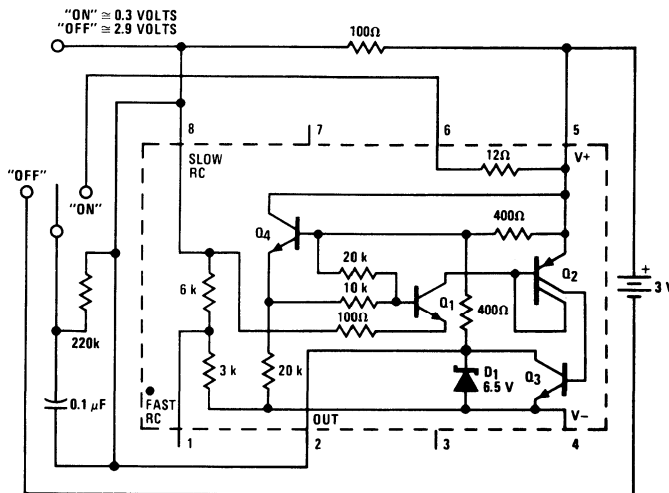


FIGURE 19. Latch Circuit

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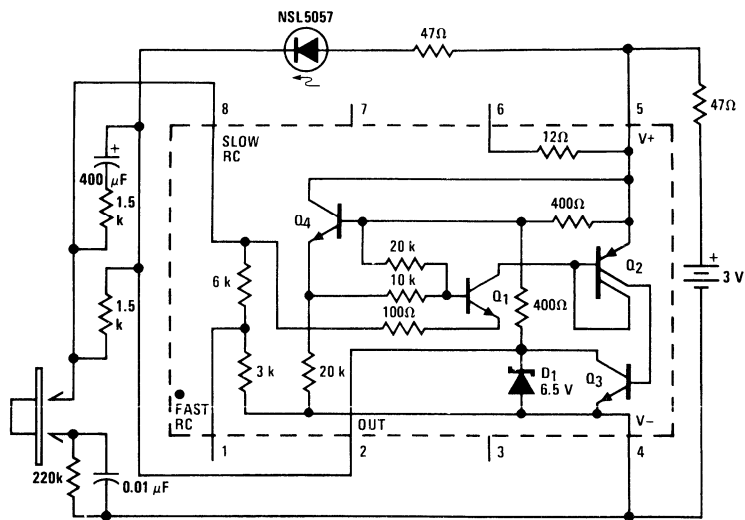


FIGURE 20. Indicating One-Shot

TL/C/7213-24

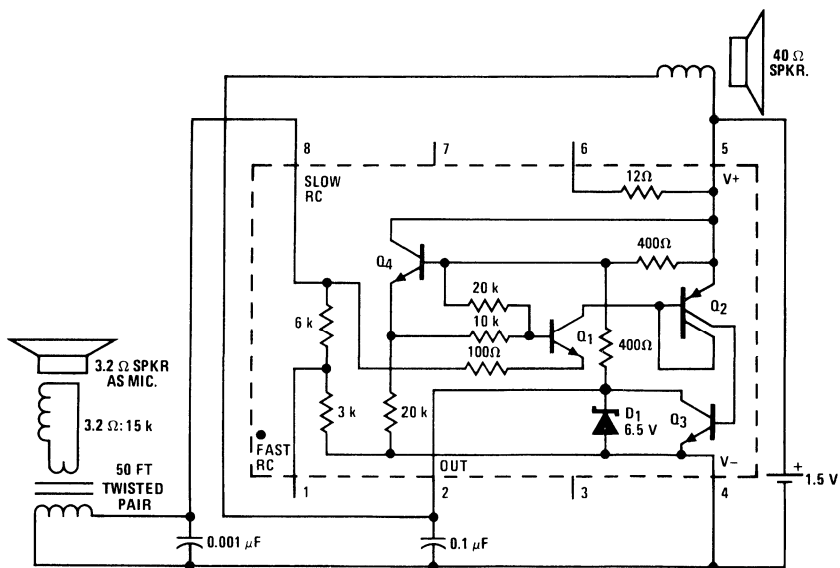


FIGURE 21. Mini-Power Amplifier

TL/C/7213-25

APPLICATION HINTS

With 1.5V supplies, certain problems can occur to stop oscillation or flashing. Due to the way gain is achieved and the type of feedback, too heavy a load may stop an LM3909 from oscillating. 20 Ω of pure resistive *load* will sometimes do it. Strangely enough, lamp filaments, probably because of some inductance, don't seem to follow this rule. Also in flasher circuits, an LED with *leakage* or conductivity between 0.9 and 1.2V will stop the LM3909. Maybe 1% of LEDs will have this defect because they are not often tested for it.

Greater frequency stability was not one of the design aims of the LM3909. In LED flasher circuits it is better than might be expected because the negative temperature coefficient of the LED partially compensates the IC. We planned it this way. Simple oscillators, without the LED, are uncompensated for temperature. This is due to using 1 2/3 of a silicon junction drop as the on-off trip point and the use of the integrated timing resistors with their positive temperature coefficient. Further, most capacitors of 1 μ F or over, shown in the circuits, will usually be electrolytics for size reasons. These, however, are not particularly stable with temperature and their initial tolerances vary greatly with type of capacitor.

In most of the oscillator circuits, frequency is also proportional to battery voltage. This must be considered when starting with a completely unused cell at 1.54V or so and deciding what the "end-of-life" voltage is to be. This can be in the range of 1.1 to 0.9V, a drastic change. It helps to remember how bright flashlights are with a fresh set of batteries, and how dim they are when the batteries are finally changed.

Flashers and tone generators for alarms are not, however, demanding for stability. Flash rate changes of 50% or tone shifts of 1/2 an octave are not particularly annoying or even too noticeable.

One interesting point is that the low operating power of most of the circuits presented allows them to be powered by *solar cells* as well as regular batteries. In bright sunlight, 3 to 4 cells in series will be needed. In dimmer light, 4 to 6 cells will do the job. Current from cells way under an inch in area

generally will be sufficient, but circuits drawing a high pulse current (such as SCR triggers) will need a surge storage capacitor across the solar cell array.

The LM3909 was designed to be inherently self-starting as an oscillator, and LED flasher circuits *are*, at any voltage, because the load is nonlinear. A load with sufficient self inductance will always self-start, although possibly at a higher than expected frequency. There is an exception for large resistive loads on an oscillator operating with a supply larger than 2 or 2.5V. A stable state exists with Q₃ turned completely "on" and the timing resistors from pin 8 to the supply minus still drawing current. A reliable solution is to bias pin 8 (for instance with a resistor to V+) so that its DC voltage is one half V less than half the supply voltage.

The duty cycle of the basic LED flasher is inherently low since the timing capacitor is also driving the very low LED "on" impedance. For other oscillators the "on" duty cycle can be stretched by adding resistance in series with the timing capacitor. Additionally, nonlinear resistance can be used as timing resistance. (See *Figure 14b*)

CONCLUSION

Applications covered in this note range in use from toys to the laboratory, and in frequency from DC to RF. The LM3909 can be used to amuse, teach, or even upon occasion to save a life. As a practical cost consideration the LM3909 IC can often replace a circuit having a number of transistors, associated parts, and high assembly cost.

Further, the LM3909 demonstrates the practicality of very low voltage electronic circuits. They can work at high efficiencies if ingenuity is used to design around transistor junction drops. In such circuits stresses on parts are so low that extremely long life can be predicted. Often transistors, capacitors, etc. that would be rejected at higher voltages can be used. Voltage dividers, protective diodes, etc. often needed at higher voltages can be left out of designs. Power drains are so low that circuits can be made that will last months to years on a single cell.

A single cell is more reliable and has a higher energy density than multiple cells. This is due to lack of cell interconnections and insulation as well as elimination of packaging to hold multiple cells in place.

Specifying A/D and D/A Converters

National Semiconductor
Application Note 156
Jim Sherwin



The specification or selection of analog-to-digital (A/D) or digital-to-analog (D/A) converters can be a chancey thing unless the specifications are understood by the person making the selection. Of course, you know you want an accurate converter of specific resolution; but how do you ensure that you get what you want? For example, 12 switches, 12 arbitrarily valued resistors, and a reference will produce a 12-bit DAC exhibiting 12 quantum steps of output voltage. In all probability, the user wants something better than the expected performance of such a DAC. Specifying a 12-bit DAC or an ADC must be made with a full understanding of accuracy, linearity, differential linearity, monotonicity, scale, gain, offset, and hysteresis errors.

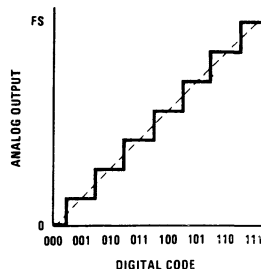
This note explains the meanings of and the relationships between the various specifications encountered in A/D and D/A converter descriptions. It is intended that the meanings be presented in the simplest and clearest practical terms. Included are transfer curves showing the several types of errors discussed. Timing and control signals and several binary codes are described as they relate to A/D and D/A converters.

MEANING OF PERFORMANCE SPECS

Resolution describes the smallest standard incremental change in output voltage of a DAC or the amount of input voltage change required to increment the output of an ADC between one code change and the next adjacent code change. A converter with n switches can resolve 1 part in 2^n . The least significant increment is then 2^{-n} , or one least significant bit (LSB). In contrast, the most significant bit (MSB) carries a weight of 2^{-1} . Resolution applies to DACs and ADCs, and may be expressed in percent of full scale or in binary bits. For example, an ADC with 12-bit resolution could resolve 1 part in 2^{12} (1 part in 4096) or 0.0244% of full scale. A converter with 10V full scale could resolve a 2.44mV input change. Likewise, a 12-bit DAC would exhibit an output voltage change of 0.0244% of full scale when the binary input code is incremented one binary bit (1 LSB). Resolution is a design parameter rather than a performance specification; it says nothing about accuracy or linearity.

Accuracy is sometimes considered to be a non-specific term when applied to D/A or A/D converters. A linearity spec is generally considered as more descriptive. An accuracy specification describes the worst case deviation of the DAC output voltage from a straight line drawn between zero and full scale; it includes all errors. A 12-bit DAC could not have a conversion accuracy better than $\pm 1/2$ LSB or ± 1 part in 2^{12+1} ($\pm 0.0122\%$ of full scale) due to finite resolution. This would be the case in *Figure 1* if there were no errors. Actually, $\pm 0.0122\%$ FS represents a deviation from 100% accuracy; therefore accuracy should be specified as 99.9878%. However, convention would dictate 0.0122% as being an accuracy spec rather than an inaccuracy (tolerance or error) spec.

Accuracy as applied to an ADC would describe the difference between the actual input voltage and the full-scale weighted equivalent of the binary output code; included are quantizing and all other errors. If a 12-bit ADC is stated to be ± 1 LSB accurate, this is equivalent to $\pm 0.0245\%$ or twice the minimum possible quantizing error of 0.0122%. An accuracy spec describes the maximum sum of all errors including quantizing error, but is rarely provided on data sheets as the several errors are listed separately.



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FIGURE 1. Linear DAC Transfer Curve Showing Minimum Resolution Error and Best Possible Accuracy

Quantizing Error is the maximum deviation from a straight line transfer function of a perfect ADC. As, by its very nature, an ADC quantizes the analog input into a finite number of output codes, only an infinite resolution ADC would exhibit zero quantizing error. A perfect ADC, suitably offset $\frac{1}{2}$ LSB at zero scale as shown in *Figure 2*, exhibits only $\pm \frac{1}{2}$ LSB maximum output error. If not offset, the error will be $-\frac{1}{2}$ LSB as shown in *Figure 3*. For example, a perfect 12-bit ADC will show a $\pm \frac{1}{2}$ LSB error of $\pm 0.0122\%$ while the quantizing error of an 8-bit ADC is $\pm \frac{1}{2}$ part in 2^8 or $\pm 0.195\%$ of full scale. Quantizing error is not strictly applicable to a DAC; the equivalent effect is more properly a resolution error.

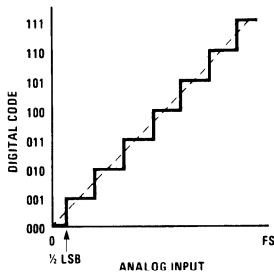


FIGURE 2. ADC Transfer Curve, $\frac{1}{2}$ LSB Offset at Zero

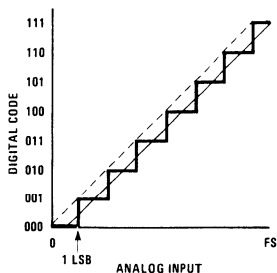


FIGURE 3. ADC Transfer Curve, No Offset

Scale Error (full scale error) is the departure from design output voltage of a DAC for a given input code, usually full-scale code. (See *Figure 4*.) In an ADC it is the departure of actual input voltage from design input voltage for a full-scale output code. Scale errors can be caused by errors in reference voltage, ladder resistor values, or amplifier gain, *et. al.* (See **Temperature Coefficient**.) Scale errors may be corrected by adjusting output amplifier gain or reference voltage. If the transfer curve resembles that of *Figure 7*, a scale adjustment at $\frac{1}{4}$ scale could improve the overall \pm accuracy compared to an adjustment at full scale.

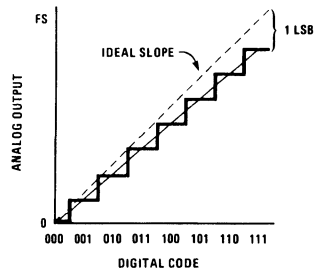


FIGURE 4. Linear, 1 LSB Scale Error

Gain Error is essentially the same as scale error for an ADC. In the case of a DAC with current and voltage mode outputs, the current output could be to scale while the voltage output could exhibit a gain error. The amplifier feedback resistors would be trimmed to correct the gain error.

Offset Error (zero error) is the output voltage of a DAC with zero code input, or it is the required mean value of input voltage of an ADC to set zero code out. (See *Figure 5*.) Offset error is usually caused by amplifier or comparator input offset voltage or current; it can usually be trimmed to zero with an offset zero adjust potentiometer external to the DAC or ADC. Offset error may be expressed in % FS or in fractional LSB.

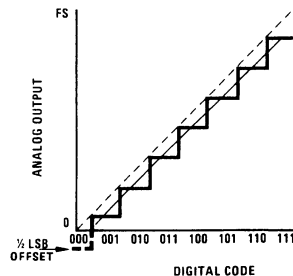


FIGURE 5. DAC Transfer Curve, $\frac{1}{2}$ LSB Offset at Zero

Hysteresis Error in an ADC causes the voltage at which a code transition occurs to be dependent upon the direction from which the transition is approached. This is usually caused by hysteresis in the comparator inside an ADC. Excessive hysteresis may be reduced by design; however, some slight hysteresis is inevitable and may be objectionable in converters if hysteresis approaches $\frac{1}{2}$ LSB.

Linearity, or, more accurately, non-linearity specifications describe the departure from a linear transfer curve for either an ADC or a DAC. Linearity error does not include quantizing, zero, or scale errors. Thus, a specification of $\pm \frac{1}{2}$ LSB

linearity implies error in addition to the inherent $\pm 1/2$ LSB quantizing or resolution error. In reference to *Figure 2*, showing no errors other than quantizing error, a linearity error allows for one or more of the steps being greater or less than the ideal shown.

Figure 6 shows a 3-bit DAC transfer curve with no more than $\pm 1/2$ LSB non-linearity, yet one step shown is of zero amplitude. This is within the specification, as the maximum deviation from the ideal straight line is ± 1 LSB ($1/2$ LSB resolution error plus $1/2$ LSB non-linearity). With any linearity error, there is a differential non-linearity (see below). A $\pm 1/2$ LSB linearity spec guarantees monotonicity (see below) and $\leq \pm 1$ LSB differential non-linearity (see below). In the example of *Figure 6*, the code transition from 100 to 101 is the worst possible non-linearity, being the transition from 1 LSB high at code 100 to 1 LSB low at 110. Any fractional non-linearity beyond $\pm 1/2$ LSB will allow for a non-monotonic transfer curve. *Figure 7* shows a typical non-linear curve; non-linearity is $1/4$ LSB yet the curve is smooth and monotonic.

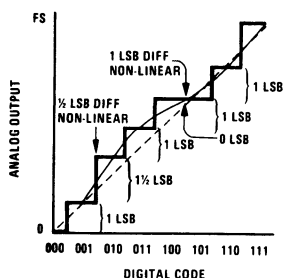


FIGURE 6. $\pm 1/2$ LSB Non-Linearity (Implies 1 LSB Possible Error), 1 LSB Differential Non-Linearity (Implies Monotonicity)

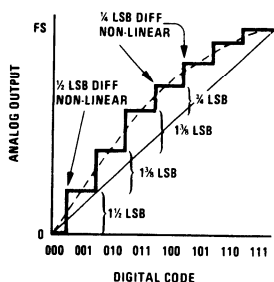


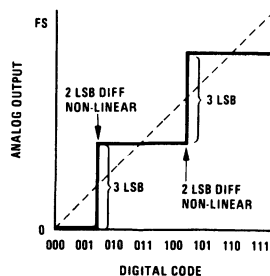
FIGURE 7. $1/4$ LSB Non-Linear, $1/2$ LSB Differential Non-Linearity

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Linearity specs refer to either ADCs or to DACs, and do not include quantizing, gain, offset, or scale errors. Linearity errors are of prime importance along with differential linearity in either ADC or DAC specs, as all other errors (except quantizing, and temperature and long-term drifts) may be adjusted to zero. Linearity errors may be expressed in % FS or fractional LSB.

Differential Non-Linearity indicates the difference between actual analog voltage change and the ideal (1 LSB) voltage change at any code change of a DAC. For example, a DAC with a 1.5 LSB step at a code change would be said to exhibit $1/2$ LSB differential non-linearity (see *Figures 6* and *7*). Differential non-linearity may be expressed in fractional bits or in % FS.

Differential linearity specs are just as important as linearity specs because the apparent quality of a converter curve can be significantly affected by differential non-linearity even though the linearity spec is good. *Figure 6* shows a curve with a $\pm 1/2$ LSB linearity and ± 1 LSB differential non-linearity while *Figure 7* shows a curve with $+1/4$ LSB linearity and $\pm 1/2$ LSB differential non-linearity. In many user applications, the curve of *Figure 7* would be preferred over that of *Figure 6* because the curve is smoother. The differential non-linearity spec describes the smoothness of a curve; therefore it is of great importance to the user. A gross example of differential non-linearity is shown in *Figure 8* where the linearity spec is ± 1 LSB and the differential linearity spec is ± 2 LSB. The effect is to allow a transfer curve with grossly degraded resolution; the normal 8-step curve is reduced to 3 steps (a 2.6-bit converter?). The real message is, "Beware of the specs." Do not ignore or omit differential linearity characteristics on a converter unless the linearity spec is tight enough to guarantee the desired differential linearity. As this characteristic is impractical to measure on a production basis, it is rarely, if ever, specified, and linearity is the primary specified parameter. Differential non-linearity can always be as much as twice the non-linearity, but no more.

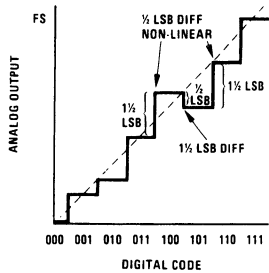


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FIGURE 8. ± 1 LSB Linear, ± 2 LSB Differential Non-Linear

Monotonicity. A monotonic curve has no change in sign of the slope; thus all incremental elements of a monotonically increasing curve will have positive or zero, but never negative slope. The converse is true for decreasing curves. The transfer curve of a monotonic DAC will contain steps of only positive or zero height, and no negative steps. Thus a smooth line connecting all output voltage points will contain no peaks or dips. The transfer function of a monotonic ADC will provide no decreasing output code for increasing input voltage.

Figure 9 shows a non-monotonic DAC transfer curve. For the curve to be non-monotonic, the linearity error must exceed $\pm 1/2$ LSB no matter by how little. The greater the linearity error, the more significant the negative step might be. A non-monotonic curve may not be a special disadvantage in some systems; however, it is a disaster in closed-loop servo systems of any type (including a DAC-controlled ADC). A $\pm 1/2$ LSB maximum linearity spec on an n-bit converter guarantees monotonicity to n bits. A converter exhibiting more than $\pm 1/2$ LSB non-linearity may be monotonic, but is not necessarily monotonic. For example, a 12-bit DAC with $\pm 1/2$ bit linearity to 10 bits (not $\pm 1/2$ LSB) will be monotonic at 10 bits but may or may not be monotonic at 12 bits unless tested and guaranteed to be 12-bit monotonic.



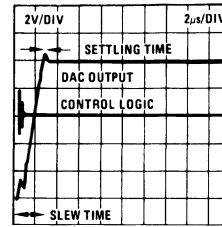
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FIGURE 9. Non-Monotonic
(Must be $> \pm 1/2$ LSB Non-Linear)

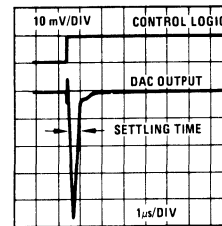
Settling Time is the elapsed time after a code transition for DAC output to reach final value within specified limits, usually $\pm 1/2$ LSB. (See also **Conversion Rate** below.) Settling time is often listed along with a slew rate specification; if so, it may not include slew time. If no slew rate spec is included, the settling time spec must be expected to include slew time. Settling time is usually summed with slew time to obtain total elapsed time for the output to settle to final value. Figure 10 delineates that part of the total elapsed time which is considered to be slew and that part which is settling time. It is apparent from this figure that the total time is greater for a major than for a minor code change due to amplifier slew limitations, but settling time may also be different depending upon amplifier overload recovery characteristics.

Slew Rate is an inherent limitation of the output amplifier in a DAC which limits the rate of change of output voltage after code transitions. Slew rate is usually anywhere from 0.2 to several hundred volts/ μ s. Delay in reaching final value of DAC output voltage is the sum of slew time and settling time as shown in Figure 10.

Overshoot and Glitches occur whenever a code transition occurs in a DAC. There are two causes. The current output of a DAC contains switching glitches due to possible asynchronous switching of the bit currents (expected to be worst at half-scale transition when all bits are switched). These



(a) Full-Scale Step



(b) 1 LSB Step

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FIGURE 10. DAC Slew and Settling Time

glitches are normally of extremely short duration but could be of $1/2$ scale amplitude. The current switching glitches are generally somewhat attenuated at the voltage output of the DAC because the output amplifier is unable to slew at a very high rate; they are, however, partially coupled around the amplifier via the amplifier feedback network and seen at the output. The output amplifier introduces overshoot and some non-critically damped ringing which may be minimized but not entirely eliminated except at the expense of slew rate and settling time.

Temperature Coefficient of the various components of a DAC or ADC can produce or increase any of the several errors as the operating temperature varies. Zero scale offset error can change due to the TC of the amplifier and comparator input offset voltages and currents. Scale error can occur due to shifts in the reference, changes in ladder resistance or non-compensating RC product shifts in dual-slope ADCs, changes in beta or reference current in current switches, changes in amplifier bias current, or drift in amplifier gain-set resistors. Linearity and monotonicity of the DAC can be affected by differential temperature drifts of the ladder resistors and switches. Overshoot, settling time, and slew rate can be affected by temperature due to internal change in amplifier gain and bandwidth. In short, every specification except resolution and quantizing error can be affected by temperature changes.

Long-Term Drift, due mainly to resistor and semiconductor aging can affect all those characteristics which temperature change can affect. Characteristics most commonly affected are linearity, monotonicity, scale, and offset. Scale change due to reference aging is usually the most important change.

Supply Rejection relates to the ability of a DAC or ADC to maintain scale, offset, TC, slew rate, and linearity when the supply voltage is varied. The reference must, of course, remain constant unless considering a multiplying DAC. Most affected are current sources (affecting linearity and scale) and amplifiers or comparators (affecting offset and slew rate). Supply rejection is usually specified only as a % FS change at or near full scale at 25°C.

Conversion Rate is the speed at which an ADC or DAC can make repetitive data conversions. It is affected by propagation delay in counting circuits, ladder switches and comparators; ladder RC and amplifier settling times; amplifier and comparator slew rates; and integrating time of dual-slope converters. Conversion rate is specified as a number of conversions per second, or conversion time is specified as a number of microseconds to complete one conversion (including the effects of settling time). Sometimes, conversion rate is specified for less than full resolution, thus showing a misleading (high) rate.

Clock Rate is the minimum or maximum pulse rate at which ADC counters may be driven. There is a fixed relationship between the minimum conversion rate and the clock rate depending upon the converter accuracy and type. All factors which affect conversion rate of an ADC limit the clock rate.

Input Impedance of an ADC describes the load placed on the analog source.

Output Drive Capability describes the digital load driving capability of an ADC or the analog load driving capacity of a DAC; it is usually given as a current level or a voltage output into a given load.

CODES

Several types of DAC input or ADC output codes are in common use. Each has its advantages depending upon the system interfacing the converter. Most codes are binary in form; each is described and compared below.

Natural Binary (or simply Binary) is the usual 2^n code with 2, 4, 8, 16, . . . , 2^n progression. An input or output high or "1" is considered a signal, whereas a "0" is considered an absence of signal. This is a positive true binary signal. Zero scale is then all "zeros" while full scale is all "ones."

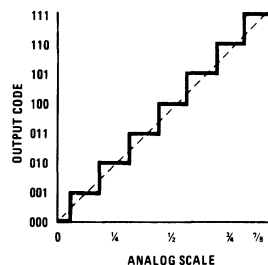
Complementary Binary (or Inverted Binary) is the negative true binary system. It is identical to the binary code except that all binary bits are inverted. Thus, zero scale is all "ones" while full scale is all "zeros."

Binary Coded Decimal (BCD) is the representation of decimal numbers in binary form. It is useful in ADC systems intended to drive decimal displays. Its advantage over decimal is that only 4 lines are needed to represent 10 digits. The disadvantage of coding DACs or ADCs in BCD is that a full 4 bits could represent 16 digits while only 10 are represented in BCD. The full-scale resolution of a BCD coded system is less than that of a binary coded system. For

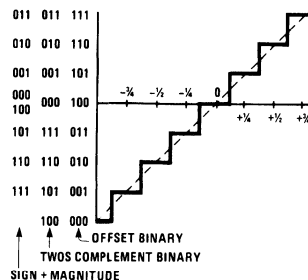
example, a 12-bit BCD system has a resolution of only 1 part in 1000 compared to 1 part in 4096 for a binary system. This represents a loss in resolution of over 4:1.

Offset Binary is a natural binary code except that it is offset (usually $\frac{1}{2}$ scale) in order to represent negative and positive values. Maximum negative scale is represented to be all "zeros" while maximum positive scale is represented as all "ones." Zero scale (actually center scale) is then represented as a leading "one" and all remaining "zeros." The comparison with binary is shown in *Figure 11*.

Two's Complement Binary is an alternate and more widely used code to represent negative values. With this code, zero and positive values are represented as in natural binary while all negative values are represented in a twos complement form. That is, the twos complement of a number represents a negative value so that interface to a computer or microprocessor is simplified. The twos complement is formed by complementing each bit and then adding a 1; any overflow is neglected. The decimal number -8 is represented in twos complement as follows: start with binary code of decimal 8 (off scale for \pm representation in 4 bits so not a valid code in the \pm scale of 4 bits) which is 1000; complement it to 0111; add 0001 to get 1000. The comparison with offset binary is shown in *Figure 11*. Note that the offset binary representation of the \pm scale differs from the twos complement representation only in that the MSB is complemented. The conversion from offset binary to twos complement only requires that the MSB be inverted.



(a) Zero to + Full-Scale



(b) \pm Full-Scale

FIGURE 11. ADC Codes

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Sign Plus Magnitude coding contains polarity information in the MSB (MSB = 1 indicates a negative sign); all other bits represent magnitude only. This code is compared to offset binary and twos complement in *Figure 11*. Note that one code is used up in providing a double code for zero. Sign plus magnitude code is used in certain instrument and audio systems; its advantage is that only one bit need be changed for small scale changes in the vicinity of zero, and plus and minus scales are symmetrical. A DVM might be an example of its use.

CONTROL

Each ADC must accept and/or provide digital control signals telling it and/or the external system what to do and when to do it. Control signals should be compatible with one or more types of logic in common use. Control signal timing must be such that the converter or connected system will accept the signals. Common control signals are listed below.

Start Conversion (SC) is a digital signal to an ADC which initiates a single conversion cycle. Typically, an SC signal must be present at the fall (or rise) of the clock waveform to initiate the cycle. A DAC needs no SC signal; however, such could be provided to gate digital inputs to a DAC.

End of Conversion (EOC) is a digital signal from an ADC which informs the external system that the digital output

data is valid. Typically, an EOC output can be connected to an SC input to cause the ADC to operate in continuous conversion mode. In non-continuous conversion systems, the SC signal is a command from the system to the ADC. A DAC does not supply an EOC signal.

Clock signals are required or must be generated within an ADC to control counting or successive approximation registers. The clock controls the conversion speed within the limitations of the ADC. DACs do not require clock signals.

CONCLUSION

Once the user has a working knowledge of DAC or ADC characteristics and specifications, he should be able to select a converter to suit a specific system need. The likelihood of overspecification, and therefore an unnecessarily high cost, is likewise reduced. The user will also be aware that specific parameters, test conditions, test circuits, and even definitions may vary from manufacturer to manufacturer. For practical production reasons, parameters may not be tested in the same manner for all converter types, even those supplied by the same manufacturer. Using information in this note, the user should, however, be able to sort out and understand those specifications (from any manufacturer) pertinent to his needs.

IC Voltage Reference has 1 ppm per Degree Drift

National Semiconductor
Application Note 161



AN-161

A new linear IC now provides the ultimate in highly stable voltage references. Now, a new monolithic IC the LM199, out-performs zeners and can provide a 6.9V reference with a temperature drift of less than 1 ppm/° and excellent long term stability. This new IC, uses a unique subsurface zener to achieve low noise and a highly stable breakdown. Included is an on-chip temperature stabilizer which holds the chip temperature at 90°C, eliminating the effects of ambient temperature changes on reference voltage.

The planar monolithic IC offers superior performance compared to conventional reference diodes. For example, active circuitry buffers the reverse current to the zener giving a dynamic impedance of 0.5Ω and allows the LM199 to operate over a 0.5 mA to 10 mA current range with no change in performance. The low dynamic impedance, coupled with low operating current significantly simplifies the current drive circuitry needed for operation. Since the temperature coefficient is independent of operating current, usually a resistor is all that is needed.

Previously, the task of providing a stable, low temperature coefficient reference voltage was left to a discrete zener diode. However, these diodes often presented significant problems. For example, ordinary zeners can show many millivolts change if there is a temperature gradient across the package due to the zener and temperature compensation diode not being at the same temperature. A 1°C difference may cause a 2 mV shift in reference voltage. Because the on-chip temperature stabilizer maintains constant die temperature, the IC reference is free of voltage shifts due to temperature gradients. Further, the temperature stabilizer, as well as eliminating drift, allows exceptionally fast warm-up over conventional diodes. Also, the LM199 is insensitive to stress on the leads—another source of error with ordinary glass diodes. Finally, the LM199 shows virtually no hysteresis in reference voltage when subject to temperature cycling over a wide temperature range. Temperature cycling the LM199 between 25°C, 150°C and back to 25°C causes less than 50 μV change in reference voltage. Standard reference diodes exhibit shifts of 1 mV to 5 mV under the same conditions.

SUB SURFACE ZENER IMPROVES STABILITY

Previously, breakdown references made in monolithic IC's usually used the emitter-base junction of an NPN transistor as a zener diode. Unfortunately, this junction breaks down at the surface of the silicon and is therefore susceptible to surface effects. The breakdown is noisy, and cannot give long-term stabilities much better than about 0.3%. Further, a surface zener is especially sensitive to contamination in the oxide or charge on the surface of the oxide which can cause short-term instability or turn-on drift.

The new zener moves the breakdown below the surface of the silicon into the bulk yielding a zener that is stable with time and exhibits very low noise. Because the new zener is made with well-controlled diffusions in a planar structure, it is extremely reproducible with an initial 2% tolerance on breakdown voltage.

A cut-away view of the new zener is shown in *Figure 1*. First a small deep P⁺ diffusion is made into the surface of the silicon. This is then covered by the standard base diffusion. The N⁺ emitter diffusion is then made completely covering the P⁺ diffusion. The diode then breaks down where the dopant concentration is greatest, that is, between the P⁺ and N⁺. Since the P⁺ is completely covered by N⁺ the breakdown is below the surface and at about 6.3V. One connection to the diode is to the N⁺ and the other is to the P base diffusion. The current flows laterally through the base to the P⁺ or cathode of the zener. Surface breakdown does not occur since the base P to N⁺ breakdown voltage is greater than the breakdown of the buried device. The buried zener has been in volume production since 1973 as the reference in the LX5600 temperature transducer.

CIRCUIT DESCRIPTION

The block diagram of the LM199 is shown in *Figure 2*. Two electrically independent circuits are included on the same chip—a temperature stabilizer and a floating active zener. The only electrical connection between the two circuits

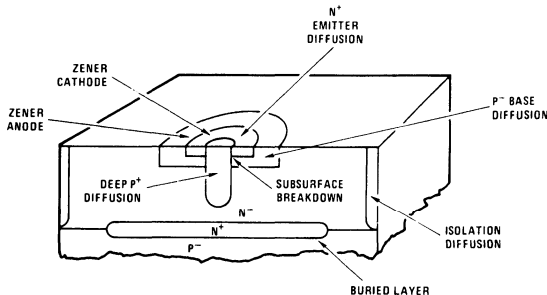


FIGURE 1. Subsurface Zener Construction

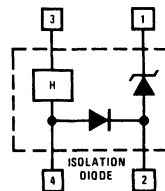


FIGURE 2. Functional Block Diagram

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is the isolation diode inherent in any junction-isolated integrated circuit. The zener may be used with or without the temperature stabilizer powered. The only operating restriction is that the isolation diode must never become forward biased and the zener must not be biased above the 40V breakdown of the isolation diode.

The actual circuit is shown in *Figure 3*. The temperature stabilizer is composed of Q1 through Q9. FET Q9 provides current to zener D2 and Q8. Current through Q8 turns a loop consisting of D1, Q5, Q6, Q7, R1 and R2. About 5V is applied to the top of R1 from the base of Q7. This causes 400 μA to flow through the divider R1, R2. Transistor Q7 has a controlled gain of 0.3 giving Q7 a total emitter current of about 500 μA . This flows through the emitter of Q6 and drives another controlled gain PNP transistor Q5. The gain of Q5 is about 0.4 so D1 is driven with about 200 μA . Once current flows through Q5, Q8 is reverse biased and the loop is self-sustaining. This circuitry ensures start-up.

The resistor divider applies 400 mV to the base of Q4 while Q7 supplies 120 μA to its collector. At temperatures below the stabilization point, 400 mV is insufficient to cause Q4 to conduct. Thus, all the collector current from Q7 is provided

as base drive to a Darlington composed of Q1 and Q2. The Darlington is connected across the supply and initially draws 140 mA (set by current limit transistor Q3). As the chip heats, the turn on voltage for Q4 decreases and Q4 starts to conduct. At about 90°C the current through Q4 appreciably increases and less drive is applied to Q1 and Q2. Power dissipation decreases to whatever is necessary to hold the chip at the stabilization temperature. In this manner, the chip temperature is regulated to better than 2°C for a 100°C temperature range.

The zener section is relatively straight-forward. A buried zener D3 breaks down biasing the base of transistor Q13. Transistor Q13 drives two buffers Q12 and Q11. External current changes through the circuit are fully absorbed by the buffer transistors rather than D3. Current through D3 is held constant at 250 μA by a 2k resistor across the emitter base of Q13 while the emitter-base voltage of Q13 nominally temperature compensates the reference voltage.

The other components, Q14, Q15 and Q16 set the operating current of Q13. Frequency compensation is accomplished with two junction capacitors.

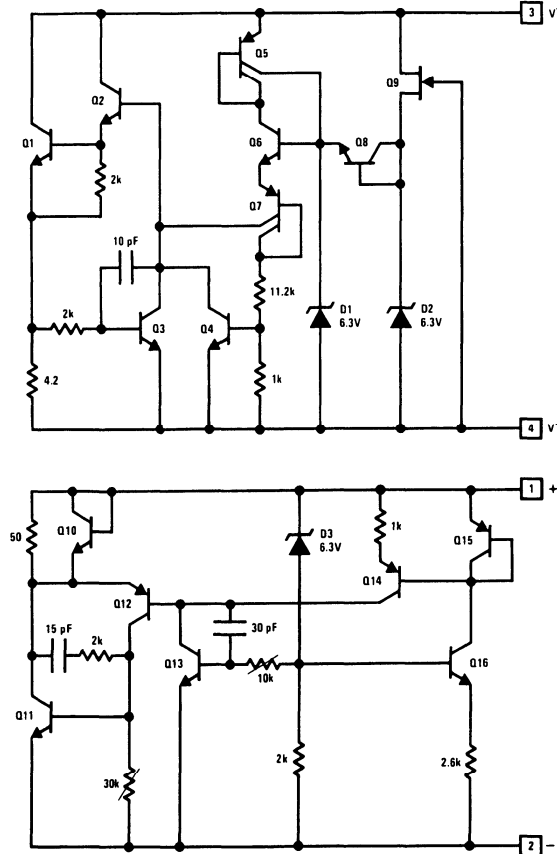
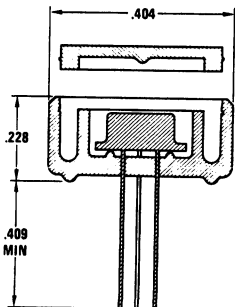


FIGURE 3. Schematic Diagram of LM199 Precision Reference

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PERFORMANCE

A polysulfone thermal shield, shown in *Figure 4*, is supplied with the LM199 to minimize power dissipation and improve temperature regulation. Using a thermal shield as well as the small, high thermal resistance TO-46 package allows operation at low power levels without the problems of special IC packages with built-in thermal isolation. Since the LM199 is made on a standard IC assembly line with standard assembly techniques, cost is significantly lower than if special techniques were used. For temperature stabilization only 300 mW are required at 25°C and 660 mW at -55°C.



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FIGURE 4. Polysulfone Thermal Shield

Temperature stabilizing the device at 90°C virtually eliminates temperature drift at ambient temperatures less than 90°C. The reference is nominally temperature compensated and the thermal regulator further decreases the temperature drift. Drift is typically only 0.3 ppm/°C. Stabilizing the temperature at 90°C rather than 125°C significantly reduces power dissipation but still provides very low drift over a major portion of the operating temperature range. Above 90°C ambient, the temperature coefficient is only 15 ppm/°C.

A low drift reference would be virtually useless without equivalent performance in long term stability and low noise. The subsurface breakdown technology yields both of these. Wideband and low frequency noise are both exceptionally low. Wideband noise is shown in *Figure 5* and low frequency noise is shown over a 10 minute period in the photograph of *Figure 6*. Peak to peak noise over a 0.01 Hz to 1 Hz bandwidth is only about 0.7 μV.

Long term stability is perhaps one of the most difficult measurements to make. However, conditions for long-term stability measurements on the LM199 are considerably more realistic than for commercially available certified zeners. Standard zeners are measured in ±0.05°C temperature controlled both at an operating current of 7.5 mA ±0.05 μA. Further, the standard devices must have stress-free contacts on the leads and the test must not be interrupted during the measurement interval. In contrast, the LM199 is measured in still air of 25°C to 28°C at a reverse current of 1 mA ±0.5%. This is more typical of actual operating conditions in instruments.

When a group of 10 devices were monitored for long-term stability, the variations all correlated, which indicates changes in the measurement system (limitation of 20 ppm) rather than the LM199.

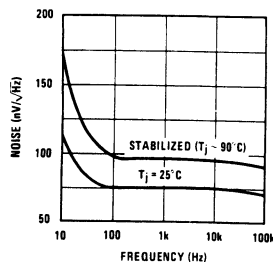
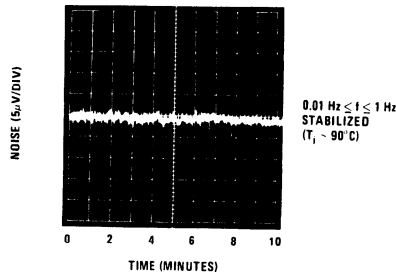


FIGURE 5. Wideband Noise of the LM199 Reference

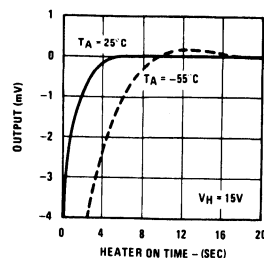


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FIGURE 6. Low Frequency Noise Voltage

Because the planar structure does not exhibit hysteresis with temperature cycling, long-term stability is not impaired if the device is switched on and off.

The temperature stabilizer heats the small thermal mass of the LM199 to 90°C very quickly. Warm-up time at 25°C and -55°C is shown in *Figure 7*. This fast warm-up is significantly less than the several minutes needed by ordinary diodes to reach equilibrium. Typical specifications are shown in Table I.



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FIGURE 7. Fast Warmup Time of the LM199

Table I. Typical Specifications for the LM199

Reverse Breakdown Voltage	6.95V
Operating Current	0.5 mA to 10 mA
Temperature Coefficient	0.3 ppm/°C
Dynamic Impedance	0.5Ω
RMS Noise (10 Hz to 10 kHz)	7μV
Long-Term Stability	≤20 ppm
Temperature Stabilizer Operating Voltage	9V to 40V
Temperature Stabilizer Power Dissipation (25°C)	300 mW
Warm-up Time	3 Seconds

APPLICATIONS

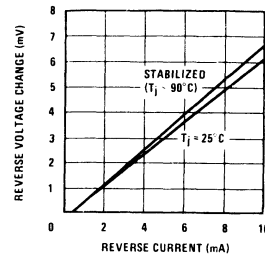
The LM199 is easier to use than standard zeners, but the temperature stability is so good—even better than precision resistors—that care must be taken to prevent external circuitry from limiting performance. Basic operation only requires energizing the temperature stabilizer from a 9V to 40V power source and biasing the reference with between 0.5 mA to 10 mA of current. The low dynamic impedance minimizes the current regulation required compared to ordinary zeners.

The only restriction on biasing the zener is the bias applied to the isolation diode. Firstly, the isolation diode must not be forward biased. This restricts the voltage at either terminal of the zener to a voltage equal to or greater than the V^- .

A dc return is needed between the zener and heater to insure the voltage limitation on the isolation diodes are not exceeded. Figure 8 shows the basic biasing of the LM199.

The active circuitry in the reference section of the LM199 reduces the dynamic impedance of the zener to about 0.5Ω . This is especially useful in biasing the reference. For example, a standard reference diode such as a 1N829 operates at 7.5 mA and has a dynamic impedance of 15Ω . A 1% change in current ($75\mu\text{A}$) changes the reference voltage by 1.1 mV. Operating the LM199 at 1 mA with the same 1% change in operating current ($10\mu\text{A}$) results in a reference change of only $5\mu\text{V}$. Figure 9 shows reverse voltage change with current.

Biasing current for the reference can be anywhere from 0.5 mA to 10 mA with little change in performance. This wide current range allows direct replacement of most zener types with no other circuit changes besides the temperature stabilizer connection. Since the dynamic impedance is constant with current changes regulation is better than discrete zeners. For optimum regulation, lower operating currents are



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FIGURE 9. The LM199 Shows Excellent Regulation Against Current Changes

preferred since the ratio of source resistance to zener impedance is higher, and the attenuation of input changes is greater. Further, at low currents, the voltage drop in the wiring is minimized.

Mounting is an important consideration for optimum performance. Although the thermal shield minimizes the heat low, the LM199 should not be exposed to a direct air flow such as from a cooling fan. This can cause as much as a 100% increase in power dissipation degrading the thermal regulation and increasing the drift. Normal convection currents do not degrade performance.

Printed circuit board layout is also important. Firstly, four wire sensing should be used to eliminate ohmic drops in pc traces. Although the voltage drops are small the temperature coefficient of the voltage developed along a copper trace can add significantly to the drift. For example, a trace with 1Ω resistance and 2 mA current flow will develop 2 mV drop. The TC of copper is $0.004\%/^\circ\text{C}$ so the 2 mV drop will change at $8\mu\text{V}/^\circ\text{C}$, this is an additional 1 ppm drift error. Of course, the effects of voltage drops in the printed circuit traces are eliminated with 4-wire operation. The heater current also should not be allowed to flow through the voltage reference traces. Over a -55°C to $+125^\circ\text{C}$ temperature

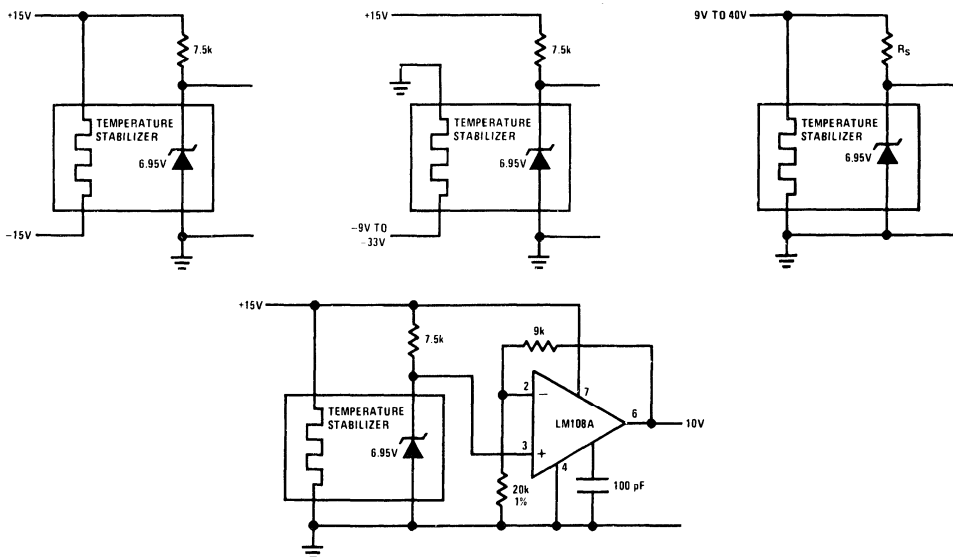


FIGURE 8. Basic Biasing of the LM199

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range the heater current will change from about 1 mA to over 40 mA. These magnitudes of current flowing reference leads or reference ground can cause huge errors compared to the drift of the LM199.

Thermocouple effects can also use errors. The kovar leads from the LM199 package from a thermocouple with copper printed circuit board traces. Since the package of the 199 is heated, there is a heat flow along the leads of the LM199 package. If the leads terminate into unequal sizes of copper on the p.c. board greater heat will be absorbed by the larger copper trace and a temperature difference will develop. A temperature difference of 1°C between the two leads of the reference will generate about $30\ \mu\text{A}$. Therefore, the copper traces to the zener should be equal in size. This will generally keep the errors due to thermocouple effects under about $15\ \mu\text{V}$.

The LM199 should be mounted flush on the p.c. board with a minimum of space between the thermal shield and the boards. This minimizes air flow across the kovar leads on the board surface which also can cause thermocouple voltages. Air currents across the leads usually appear as ultra-low frequency noise of about $10\ \mu\text{V}$ to $20\ \mu\text{V}$ amplitude.

It is usually necessary to scale and buffer the output of any reference to some calibrated voltage. Figure 10 shows a simple buffered reference with a 10V output. The reference is applied to the non-inverting input of the LM108A. An RC rolloff can be inserted in series with the input to the LM108A to roll-off the high frequency noise. The zener heater and op amp are all powered from a single 15V supply. About 1%

regulation on the input supply is adequate contributing less than $10\ \mu\text{V}$ of error to the output. Feedback resistors around the LM308 scale the output to 10V.

Although the absolute values of the resistors are not extremely important, tracking of temperature coefficients is vital. The $1\ \text{ppm}/^{\circ}\text{C}$ drift of the LM199 is easily exceeded by the temperature coefficient of most resistors. Tracking to better than $1\ \text{ppm}$ is also not easy to obtain. Wirewound types made of Evenohm or Manganin are good and also have low thermoelectric effects. Film types such as Vishay resistors are also good. Most potentiometers do not track fixed resistors so it is a good idea to minimize the adjustment range and therefore minimize their effects on the output TC. Overall temperature coefficient of the circuit shown in Figure 10 is worst case $3\ \text{ppm}/^{\circ}\text{C}$. About $1\ \text{ppm}$ is due to the reference, $1\ \text{ppm}$ due to the resistors and $1\ \text{ppm}$ due to the op amp.

Figure 11 shows a standard cell replacement with a 1.01V output. A LM321 and LM308 are used to minimize op amp drift to less than $1\ \mu\text{V}/^{\circ}\text{C}$. Note the adjustment connection which minimizes the TC effects of the pot. Set-up for this circuit requires nulling the offset of the op amp first and then adjusting for proper output voltage.

The drift of the LM321 is very predictable and can be used to eliminate overall drift of the system. The drift changes at $3.6\ \mu\text{V}/^{\circ}\text{C}$ per millivolt of offset so $1\ \text{mV}$ to $2\ \text{mV}$ of offset can be introduced to minimize the overall TC.

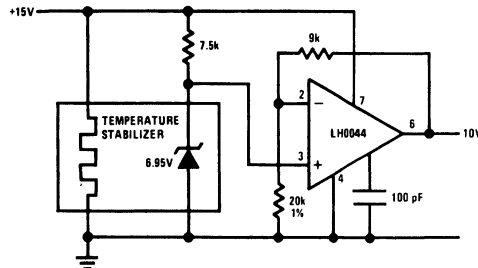


FIGURE 10. Buffered 10V Reference

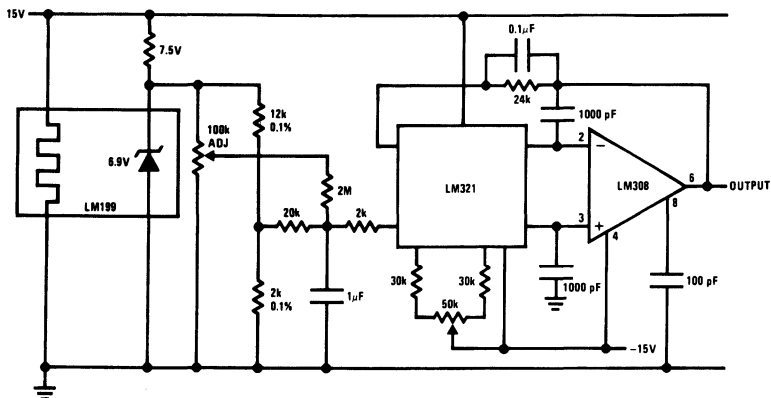


FIGURE 11. Standard Cell Replacement

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For circuits with a wide input voltage range, the reference can be powered from the output of the buffer as is shown in *Figure 12*. The op amp supplies regulated voltage to the resistor biasing the reference minimizing changes due to input variation. There is some change due to variation of the temperature stabilizer voltage so extremely wide range operation is not recommended for highest precision. An additional resistor (shown 80 k Ω) is added to the unregulated input to insure the circuit starts up properly at the application of power.

A precision power supply is shown in *Figure 13*. The output of the op amp is buffered by an IC power transistor the LM395. The LM395 operates as an NPN power device but requires only 5 μ A base current. Full overload protection inherent in the LM395 includes current limit, safe-area protection, and thermal limit.

A reference which can supply either a positive or a negative continuously variable output is shown in *Figure 14*. The reference is biased from the ± 15 input supplies as was shown

earlier. A ten-turn pot will adjust the output from $+V_Z$ to $-V_Z$ continuously. For negative output the op amp operates as an inverter while for positive outputs it operates as a non-inverting connection.

Op amp choice is important for this circuit. A low drift device such as the LM108A or a LM108-LM121 combination will provide excellent performance. The pot should be a precision wire wound 10 turn type. It should be noted that the output of this circuit is not linear.

CONCLUSIONS

A new monolithic reference which exceeds the performance of conventional zeners has been developed. In fact, the LM199 performance is limited more by external components than by reference drift itself. Further, many of the problems associated with conventional zeners such as hysteresis, stress sensitivity and temperature gradient sensitivity have also been eliminated. Finally, long-term stability and noise are equal of the drift performance of the new device.

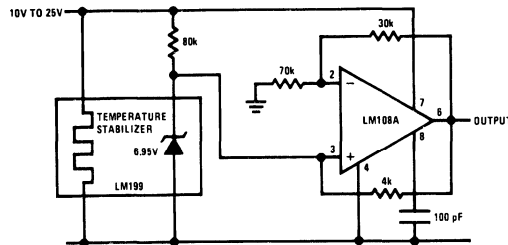


FIGURE 12. Wide Range Input Voltage Reference

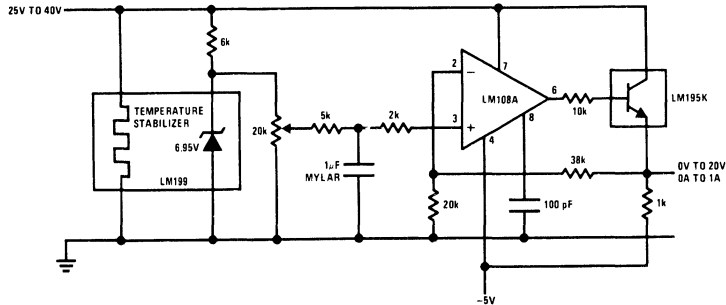


FIGURE 13. Precision Power Supply

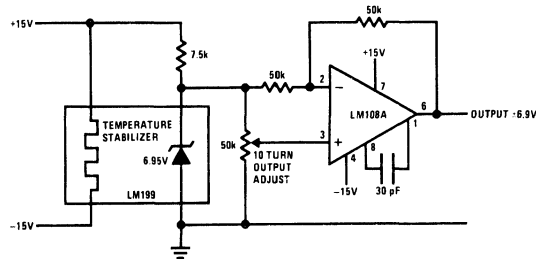


FIGURE 14. Bipolar Output Reference

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LM2907 Tachometer/Speed Switch Building Block Applications

National Semiconductor
Application Note 162



AN-162

INTRODUCTION

Frequency to voltage converters are available in a number of forms from a number of sources, but invariably require significant additional components before they can be put to use in a given situation. The LM2907, LM2917 series of devices was developed to overcome these objections. Both input and output interface circuitry is included on chip so that a minimum number of additional components is required to complete the function. In keeping with the systems building block concept, these devices provide an output voltage which is proportional to input frequency and provide zero output at zero frequency. In addition, the input may be referred to ground. The devices are designed to operate

from a single supply voltage, which makes them particularly suitable for battery operation.

PART 1—GENERAL OPERATION PRINCIPLES

Circuit Description

Referring to *Figure 1*, the family of devices all include three basic components: an input amplifier with built-in hysteresis; a charge pump frequency to voltage converter; and a versatile op amp/comparator with an uncommitted output transistor. LM2917 incorporates an active zener regulator on-chip. LM2907 deletes this option. Both versions are obtainable in 14-pin and in 8-pin dual-in-line molded packages, and to special order in other packages.

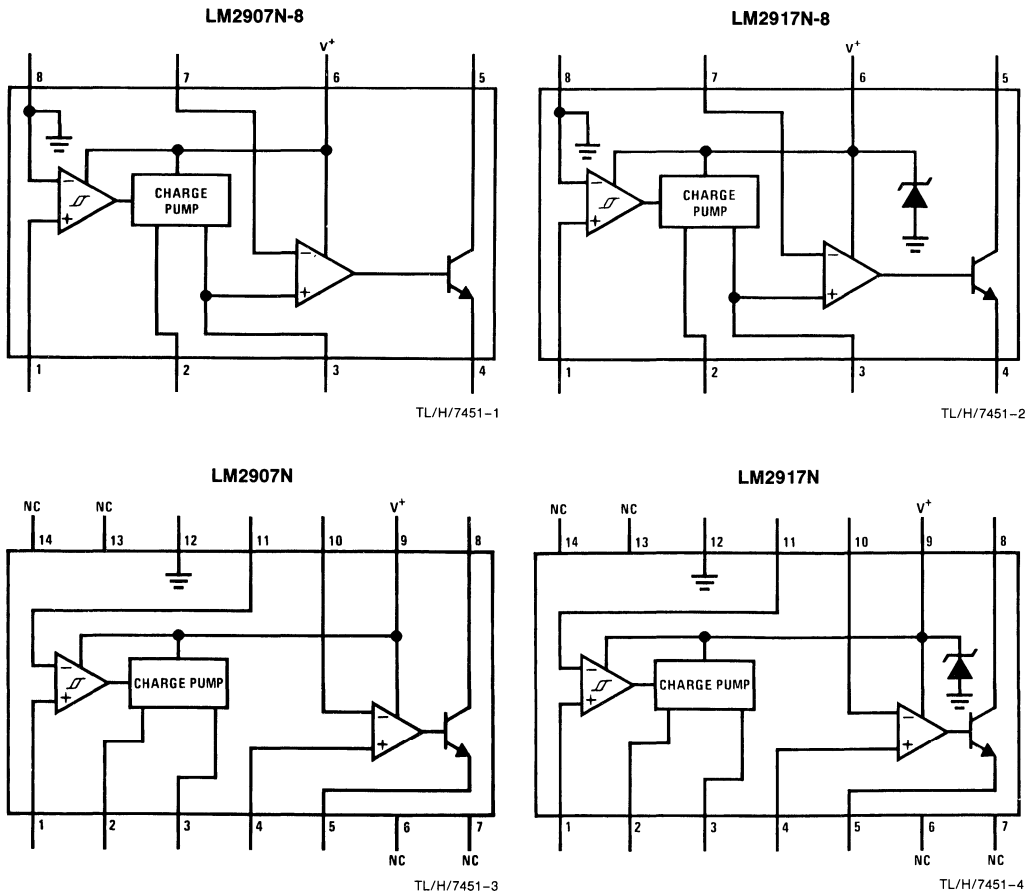


FIGURE 1. Block Diagrams

Input Hysteresis Amplifier

The equivalent schematic diagram is shown in *Figure 2*. Q1 through Q11 comprise the input hysteresis amplifier. Q1 through Q4 comprise an input differential amplifier which, by virtue of PNP level shifting, enables the circuit to operate with signals referenced to ground. Q7, Q8, D4, and D5 comprise an active load with positive feedback. This load behaves as a bi-stable flip-flop which may be set or reset depending upon the currents supplied from Q2 and Q3. Consider the situation where Q2 and Q3 are conducting equally, i.e. the input differential voltage is zero. Assuming Q7 to be conducting, it will be noted that the current from Q3 will be drawn by Q7 and Q8 will be in the "OFF" state. This allows the current from Q2 to drive Q7 in parallel with D4 and a small resistor. D4 and Q7 are identical geometry devices, so that the resistor causes Q7 to be biased at a higher level than D4. Thus Q7 will be able to conduct more current than Q3 provides. In order to reverse the state of Q7 and Q8, it will be necessary to reduce the current from Q2 below that provided by Q3 by an amount which is established by R1. It can be shown that this requires a differential input to Q1 and Q4, of approximately 15mV. Since the circuit is symmetrical, the threshold voltage to reverse the state is 15 mV in the other direction. Thus the input amplifier has built-in hysteresis at ± 15 mV. This provides clean switching where noise may be present on the input signal, and allows total rejection of noise below this amplitude where there is no input signal.

Charge Pump

The charge pump is composed of Q12 through Q32. R4, R5, and R6 provide reference voltages equal to 1/4 and 3/4 of supply voltage to Q12 and Q13. When Q10 turns "ON" or "OFF," the base voltage at Q16 changes by an amount equal to the voltage across R5, that is $1/2 V_{CC}$. A capacitor connected between Pin 2 and ground is either charged by Q21 or discharged by Q22 until its voltage matches that on the base of Q16. When the voltage on Q16 base goes low, Q16 turns "ON," which results in Q18 and Q26 turning on, which causes the current, sourced by Q19 and Q20, to be shunted to ground. Thus Q21 is unable to charge pin 2. Meanwhile, Q27 and Q30 are turned off permitting the 200 μ A sourced by Q28 and Q29 to enter the emitters of Q31 and Q32 respectively. The current from Q31 is mirrored by Q22 through Q24 resulting in a 200 μ A discharge current through pin 2. The external capacitor on pin 2 is thus discharged at a constant rate until it reaches the new base voltage on Q16. The time taken for this discharge to occur is given by:

$$t = \frac{CV}{I} \quad (1)$$

where C = capacitor on pin 2

V = change in voltage on Q16 base

I = current in Q22

During this time, Q32 sources an identical current into pin 3. A capacitor connected to pin 3 will thus be charged by the same current for the same amount of time as pin 2. When the base voltage on Q16 goes high, Q18 and Q26 are turned off while Q27 and Q3 are turned "ON." In these conditions, Q21 and Q25 provide the currents to charge the capacitors on pins 2 and 3 respectively. Thus the charge

required to return the capacitor on pin 2 to the high level voltage is duplicated and used to charge the capacitor connected to pin 3. Thus in one cycle of input the capacitor on pin 3 gets charged twice with a charge of CV.

Thus the total charge pumped into the capacitor on pin 3 per cycle is:

$$Q = 2 CV \quad (2)$$

Now, since $V = V_{CC}/2$

then $Q = CV_{CC}$ (3)

A resistor connected between pin 3 and ground causes a discharge of the capacitor on pin 3, where the total charge drained per cycle of input signal is equal to:

$$Q1 = \frac{V3 \cdot T}{R}$$

where V3 = the average voltage on pin 3

T = period of input signal

R = resistor connected to pin 3

In equilibrium $Q = Q1$

$$\text{i.e., } CV_{CC} = \frac{V3 \cdot T}{R} \quad (4)$$

and $V3 = V_{CC} \cdot \frac{RC}{T}$ (5)

or $V3 = V_{CC} \cdot R \cdot C \cdot f$ (6)

where f = input frequency

Op Amp/Comparator

Again referring to *Figure 2*, the op amp/comparator includes Q35 through Q45. A PNP input stage again provides input common-mode voltages down to zero, and if pin 8 is connected to V_{CC} and the output taken from pin 5, the circuit behaves as a conventional, unity-gain-compensated operational amplifier. However, by allowing alternate connections of Q45 the circuit may be used as a comparator in which loads to either V_{CC} or ground may be switched. Q45 is capable of sinking 50 mA. Input bias current is typically 50 nA, and voltage gain is typically 200 V/mV. Unity gain slew rate is 0.2 V/ μ s. When operated as a comparator Q45 emitter will switch at the slew rate, or the collector of Q45 will switch at that rate multiplied by the voltage gain of Q45, which is user selectable.

Active Zener Regulator

The optional active zener regulator is also shown in *Figure 2*. D8 provides the voltage reference in conjunction with Q33. As the supply voltage rises, D8 conducts and the base voltage on Q33 starts to rise. When Q33 has sufficient base voltage to be turned "ON," it in turn causes Q34 to conduct current from the power source. This reduces the current available for D8 and the negative feedback loop is thereby completed. The reference voltage is therefore the zener voltage on D8 plus the emitter base voltage of Q33. This results in a low temperature coefficient voltage.

Input Levels and Protection

In 8-pin versions of the LM2907, LM2917, the non-inverting input of the op amp/comparator is connected to the output of the charge pump. Also, one input to the input hysteresis amplifier is connected to ground. The other input (pin 1) is then protected from transients by, first a 10k Ω series resis-

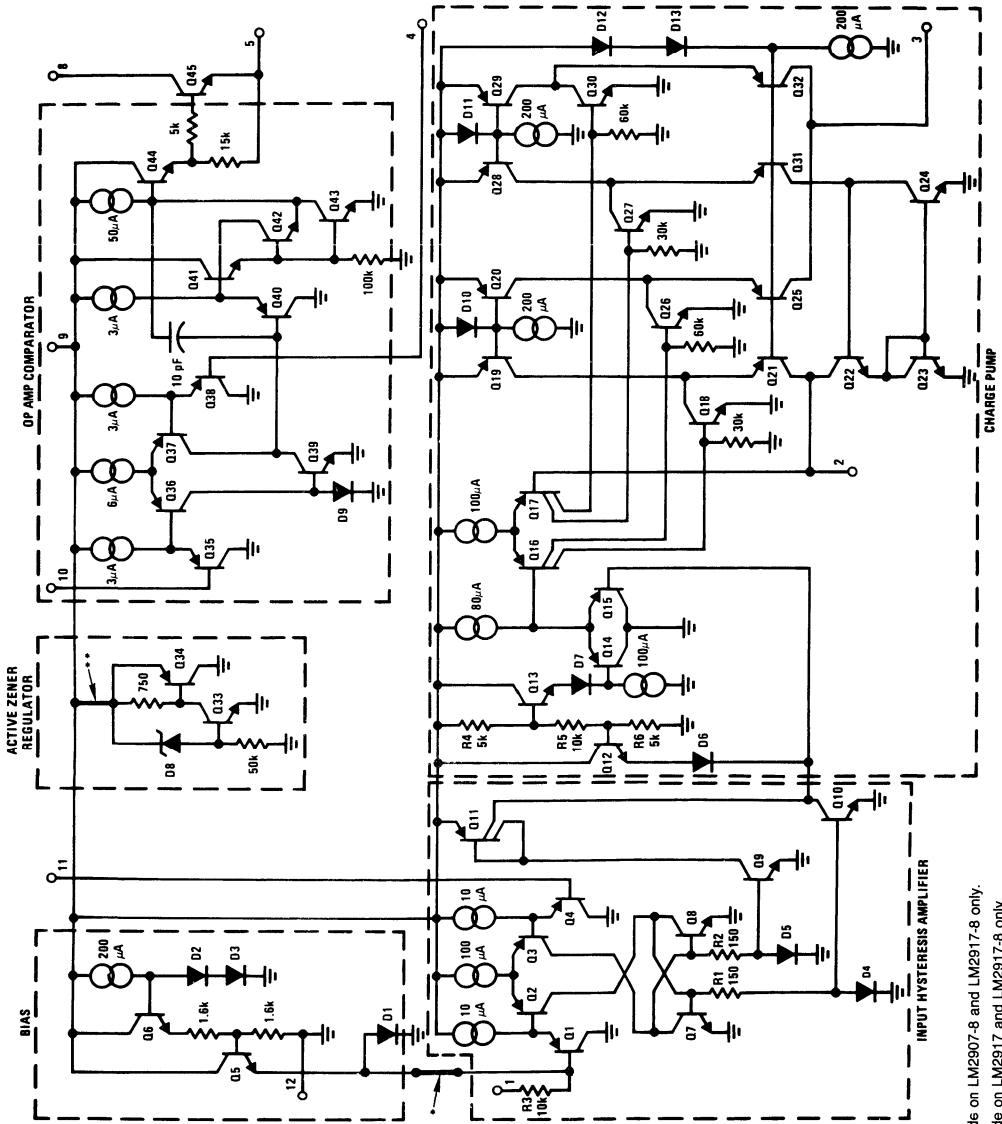


FIGURE 2. Equivalent Schematic Diagram

*Note: This connection made on LM2907-8 and LM2917-8 only.

**Note: This connection made on LM2917 and LM2917-8 only.

Note: Pin numbers refer to 14-pin package.

tor, R3 (Figure 2) which is located in a floating isolation pocket, and secondly by clamp diode D1. Since the voltage swing on the base of Q1 is thus restricted, the only restriction on the allowable voltage on pin 1 is the breakdown voltage of the 10 kΩ resistor. This allows input swings to ±28V. In 14-pin versions the link to D1 is opened in order to allow the base of Q1 to be biased at some higher voltage. Q5 clamps the negative swing on the base of Q1 to about 300 mV. This prevents substrate injection in the region of Q1 which might otherwise cause false switching or erroneous discharge of one of the timing capacitors.

The differential input options (LM2907-14, LM2917-14), give the user the option of setting his own input switching level and still having the hysteresis around that level for excellent noise rejection in any application.

HOW TO USE IT

Basic f to V Converter

The operation of the LM2907, LM2917 series is best understood by observing the basic converter shown in Figure 3. In this configuration, a frequency signal is applied to the input of the charge pump at pin 1. The voltage appearing at pin 2 will swing between two values which are approximately $1/4 (V_{CC}) - V_{BE}$ and $3/4 (V_{CC}) - V_{BE}$. The voltage at pin 3 will have a value equal to $V_{CC} \cdot f_{IN} \cdot C1 \cdot R1 \cdot K$, where K is the gain constant (normally 1.0).

The emitter output (pin 4) is connected to the inverting input of the op amp so that pin 4 will follow pin 3 and provide a low impedance output voltage proportional to input frequency. The linearity of this voltage is typically better than 0.3% of full scale.

Choosing R1, C1 and C2

There are some limitations on the choice of R1, C1 and C2 (Figure 3) which should be considered for optimum performance. C1 also provides internal compensation for the charge pump and should be kept larger than 100 pF. Smaller values can cause an error current on R1, especially at low temperatures. Three considerations must be met when choosing R1.

First, the output current at pin 3 is internally fixed and therefore V3 max, divided by R1, must be less than or equal to this value.

$$\therefore R1 \geq \frac{V3 \text{ max}}{I_{3\text{MIN}}}$$

where V3 max is the full scale output voltage required

$I_{3\text{MIN}}$ is determined from the data sheet (150 μA)

Second, if R1 is too large, it can become a significant fraction of the output impedance at pin 3 which degrades linearity. Finally, ripple voltage must be considered, and the size of C2 is affected by R1. An expression that describes the ripple content on pin 3 for a single R1, C2 combination is:

$$V_{\text{RIPPLE}} = \frac{V_{CC}}{2} \cdot \frac{C1}{C2} \left(1 - \frac{V_{CC} \cdot f_{IN} \cdot C1}{I_2} \right) p-p$$

It appears R1 can be chosen independent of ripple, however response time, or the time it takes V_{OUT} to stabilize at a new frequency increases as the size of C2 increases, so a compromise between ripple, response time, and linearity must be chosen carefully. R1 should be selected according to the following relationship:

C is selected according to:

$$C1 = \frac{V3 \text{ Full Scale}}{R1 \cdot V_{CC} \cdot f_{\text{FULL SCALE}}}$$

Next decide on the maximum ripple which can be accepted and plug into the following equation to determine C2:

$$C2 = \frac{V_{CC}}{2} \cdot \frac{C1}{V_{\text{RIPPLE}}} \left(1 - \frac{V3}{R1 I_2} \right)$$

The kind of capacitor used for timing capacitor C1 will determine the accuracy of the unit over the temperature range. Figure 15 illustrates the tachometer output as a function of temperature for the two devices. Note that the LM2907 operating from a fixed external supply has a negative temperature coefficient which enables the device to be used with capacitors which have a positive temperature coefficient and thus obtain overall stability. In the case of the LM2917 the internal zener supply voltage has a positive coefficient which causes the overall tachometer output to have a very low temperature coefficient and requires that the capacitor temperature coefficient be balanced by the temperature coefficient of R1.

Using Zener Regulated Options (LM2917)

For those applications where an output voltage or current must be obtained independently of the supply voltage variations, the LM2917 is offered. The reference typically has an 11Ω source resistance. In choosing a dropping resistor from the unregulated supply to the device note that the tachometer and op amp circuitry alone require about 3 mA at the voltage level provided by the zener. At low supply voltages,

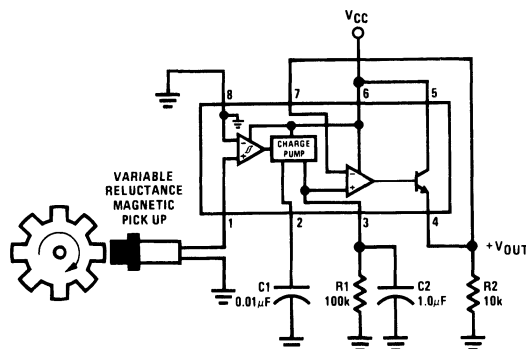
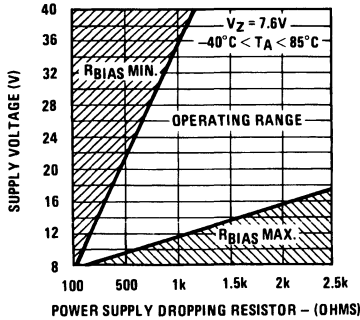


FIGURE 3. Basic f to V Converter

TL/H/7451-6

there must be some current flowing in the resistor above the 3 mA circuit current to operate the regulator. As an example, if the raw supply varies from 9V to 16V, a resistance of 470Ω will minimize these zener voltage variations to 160 mV. If the resistor goes under 400Ω or over 600Ω the zener variation quickly rises above 200 mV for the same input variation. Take care also that the power dissipation of the IC is not exceeded at higher supply voltages. Figure 4 shows suitable dropping resistor values.

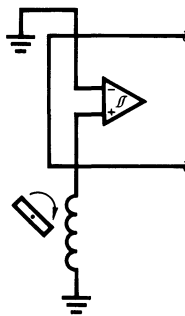


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FIGURE 4. Zener Regular Bias Resistor Range

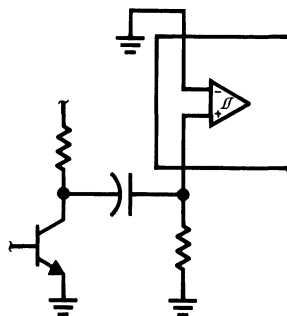
Input Interface Circuits

The ground referenced input capability of the LM2907-8 allows direct coupling to transformer inputs, or variable reluctance pickups. Figure 5(a) illustrates this connection. In many cases, the frequency signal must be obtained from another circuit whose output may not go below ground. This may be remedied by using ac coupling to the input of the LM2907 as illustrated in Figure 5(b). This approach is very suitable for use with phototransistors for optical pickups. Noisy signal sources may be coupled as shown in Figure 5(c). The signal is bandpass filtered. This can be used, for example, for tachometers operating from breakerpoints on a conventional Kettering ignition system. Remember that the minimum input signal required by the LM2907 is only 30 mVp-p, but this signal must be able to swing at least 15 mV on either side of the inverting input. The maximum signal which can be applied to the LM2907 input, is ±28V. The input bias current is a typically 100 nA. A path to ground must be provided for this current through the source or by other means as illustrated. With 14-pin package versions of LM2907, LM2917, it is possible to bias the inverting input to the tachometer as illustrated in Figure 5(d). This enables the circuit to operate with input signals that do not go to ground, but are referenced at higher voltages. Alternatively, this method increases the noise immunity where large signal



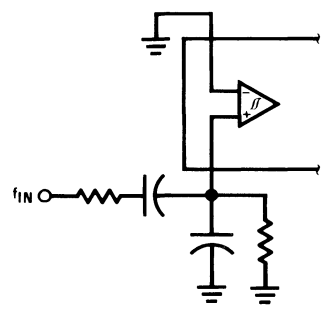
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(a) Ground Referenced Inputs



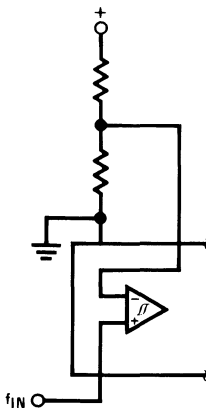
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(b) AC Coupled Input



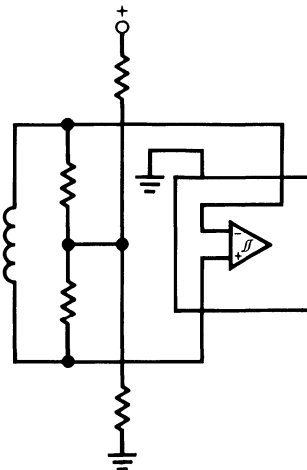
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(c) Bandpass Filtered Input Reduces Noise



TL/H/7451-11

(d) Above Ground Sensing



TL/H/7451-12

(e) High Common-Mode Rejection Input Circuit

FIGURE 5. Tachometer Input Configurations

levels are available but large noise signals on ground are also present. To take full advantage of the common-mode rejection of the input differential stage, a balanced bias configuration must be provided. One such circuit is illustrated in Figure 5(e). With this arrangement, the effective common-mode rejection may be virtually infinite, owing to the input hysteresis.

Output Configurations

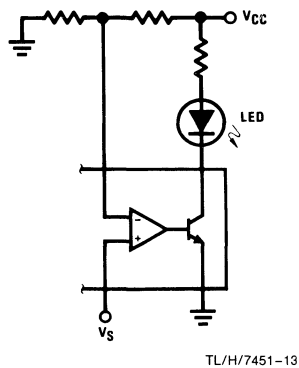
LM2907, LM2917 series devices incorporate an unusually flexible op amp/comparator device on-chip for interfacing with a wide variety of loads. This flexibility results from the availability of both the collector and emitter of the output transistor which is capable of driving up to 50 mA of load current. When the non-inverting input is higher than the inverting input, this output transistor is turned "ON". It may be used to drive loads to either the positive or the negative supply with the emitter or collector respectively connected to the other supply. For example, Figure 6(a), a simple speed switch can be constructed in which the speed signal derived from the frequency to voltage converter is compared to a reference derived simply by a resistive divider from the power supply. When the speed signal exceeds the reference, the output transistor turns on the light emitting diode in the load. A small current limiting resistor should be

placed in series with the output to protect the LED and the output transistor.

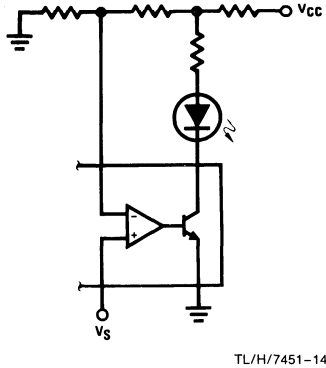
This circuit has no hysteresis in it, i.e., the turn "ON" and turn "OFF" speed voltages are essentially equal. In cases where speed may be fluctuating at a high rate and a flashing LED would be objectionable, it is possible to incorporate hysteresis so that the switch-on speed is above the switch-off speed by a controlled amount. Such a configuration is illustrated in Figure 6(b). Figure 6(c) shows how a grounded load can also be switched by the circuit. In this case, the current limiting resistor is placed in the collector of the power transistor. The base current of the output transistor (Q45) is limited by a 5 kΩ base resistor (see Figure 2). This raises the output resistance so that the output swing will be reduced at full load.

The op amp/comparator is internally compensated for unity gain feedback configurations as in Figure 6(d). By directly connecting the emitter output to the non-inverting input, the op amp may be operated as a voltage follower. Note that a load resistor is required externally. The op amp can also be operated, of course, as an amplifier, integrator, active filter, or in any other normal operational amplifier configuration.

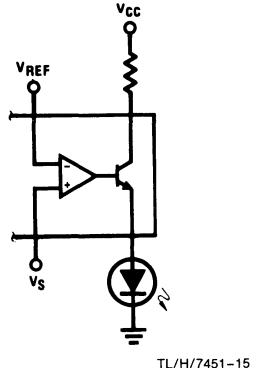
One unique configuration which is not available with standard operational amplifiers, is shown in Figure 6(e). Here the collector of the output transistor is used to drive a load



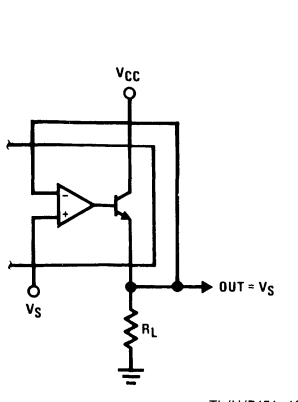
(a) Switching an LED



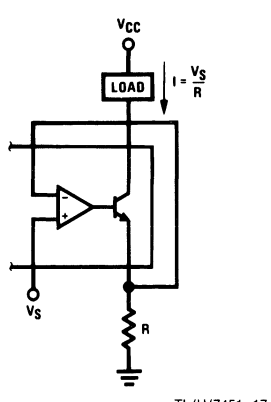
(b) Adding Hysteresis to LED Switch



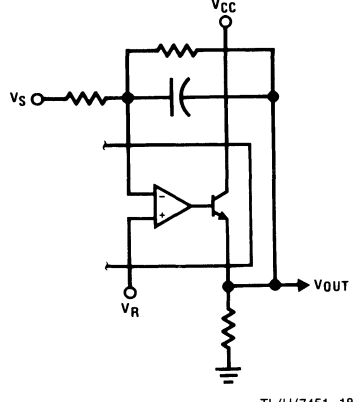
(c) Switching a Grounded Load



(d) Voltage Follower



(e) Voltage to Current Converter



(f) Integrator

FIGURE 6. Output Configurations

with a current which is proportional to the input voltage. In other words, the circuit is operating as a voltage to current converter. This is ideal for driving remote signal sensors and moving coil galvanometers. *Figure 6(f)* shows how an active integrator can be used to provide an output which falls with increasing speed.

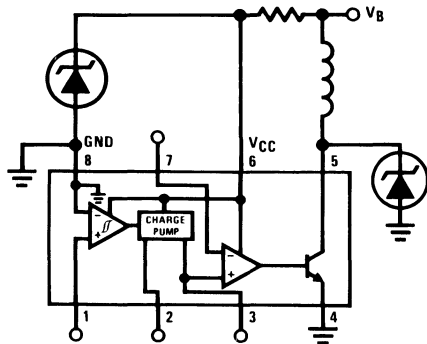
These are the basic configurations obtainable with the op amp/comparator. Further combinations can be seen in the applications shown in Part II of this application note.

Transient Protection

Many application areas use unregulated power supplies which tend to expose the electronics to potentially damaging transients on the power supply line. This is particularly true in the case of automotive applications where two such transients are common.¹ First is the load dump transient. This occurs when a dead battery is being charged at a high current and the battery cable comes loose, so that the current in the alternator inductance produces a positive transient on the line in the order of 60V to 120V. The second transient is called field decay. This occurs when the ignition is turned "OFF" and the energy stored in the field winding of the alternator causes a negative 75V transient on the ignition line.

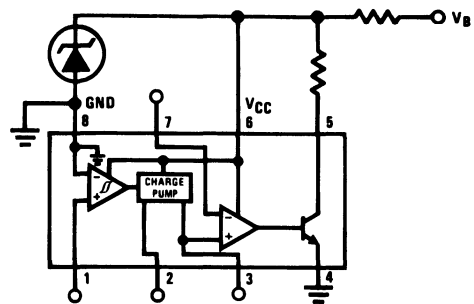
Figure 7 illustrates methods for protecting against these and other transients. *Figure 7(a)* shows a typical situation in which the power supply to the LM2907 can be provided through a dropping resistor and regulated by an external zener diode Z1, but the output drive is required to operate from the full available supply voltage. In this case, a separate protection zener Z2 must be provided if the voltage on the power line is expected to exceed the maximum rated voltage of the LM2907.

In *Figure 7(b)* and *Figure 7(c)*, the output transistor is required only to drive a simple resistive load and no secondary protection circuits are required. (Note that the dropping resistor to the zener also has to supply current to the output circuit). With the foregoing circuits, reverse supply protection is supplied by the forward biased zener diode. This device should be a low forward resistance unit in order to limit the maximum reverse voltage applied to the integrated circuit. Excessive reverse voltage on the IC can cause high currents to be conducted by the substrate diodes with consequent danger of permanent damage. Up to 1V negative can generally be tolerated. Versions with internal zeners may be self-protecting depending on the size of dropping resistor used. In applications where large negative voltage



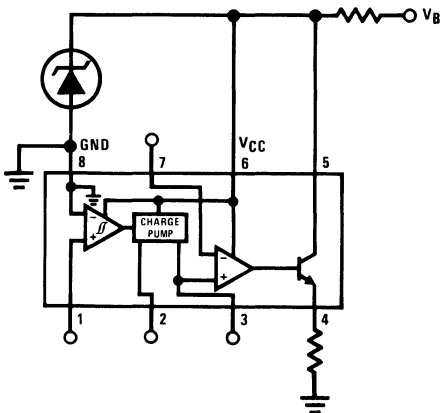
(a)

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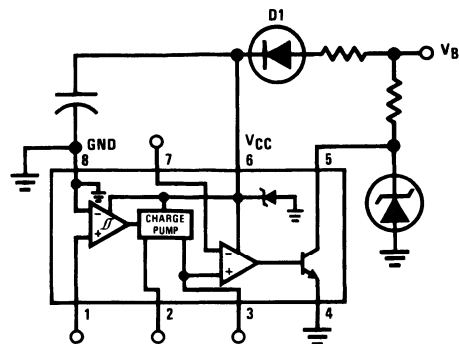
(b)

TL/H/7451-20



(c)

TL/H/7451-21



(d)

TL/H/7451-22

FIGURE 7. Transient Protection Schemes

transients may be anticipated, a blocking diode may be connected in the power supply line to the IC as illustrated in *Figure 7(d)*. During these negative transients, the diode D1 will be reverse biased and prevent reverse currents flowing in the IC. If these transients are short and the capacitor C1 is large enough, then the power to the IC can be sustained. This is useful to prevent change of state or change of charge in in systems connected to it.

Temperature Ranges and Packaging Considerations

The LM2907, LM2917 series devices are specified for operation over the temperature range -40°C to +85°C.

The devices are normally packaged in molded epoxy, dual-in-line packages. Other temperature ranges and other packages are available to special order. For reliability requirements beyond those of normal commercial application where the cost of military qualification is not bearable, other programs are available such as B+.

PART II—APPLICATIONS

INTRODUCTION

The LM 2907, LM2917 series devices were designed not only to perform the basic frequency to voltage function required in many systems, but also to provide the input and output interface so often needed, so that low cost implementations of complete functions are available.

The concept of building blocks requires that a function be performed in the same way as it can be mathematically defined. In other words, a frequency to voltage converter will provide an output voltage proportional to frequency which is independent of the input voltage or other input parameters, except the frequency. In the same way, the output voltage will be zero when the input frequency is zero. These features are built into the LM2907.

Applications for the device range from simple speed switch for anti-pollution control device functions in automobiles, to motor speed controls in industrial applications. The applications circuits which follow are designed to illustrate some of the capabilities of the LM2907. In most cases, alternative input or output configurations can be mixed and matched at will and other variations can be determined from the description in Part I of this application note. For complete specifications, refer to the data sheet.

Speed Switches

Perhaps the most natural application of the LM2907 is in interfacing with magnetic pickups, such as the one illustrated in *Figure 8* to perform speed switching functions. As an example, New York taxis are required to change the intensity of the warning horn above and below 45 mph. Other examples include an over-speed warning, where a driver may set the desired maximum speed and have an audible

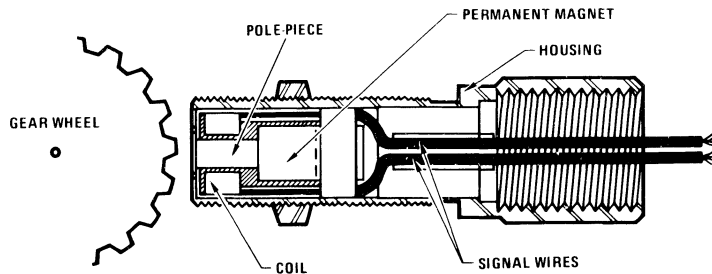


FIGURE 8. Typical Magnetic Pickup

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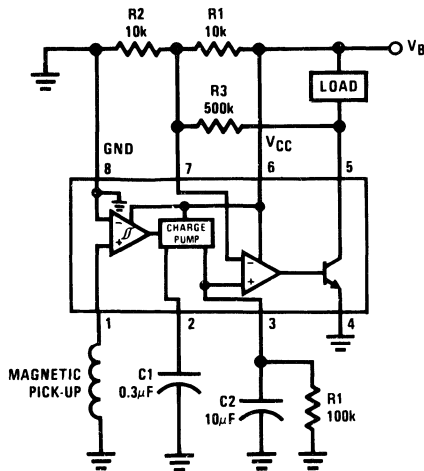


FIGURE 9. Simple Speed Switch Load is Energized

$$\text{when } f_{IN} > \frac{1}{2C1R1}$$

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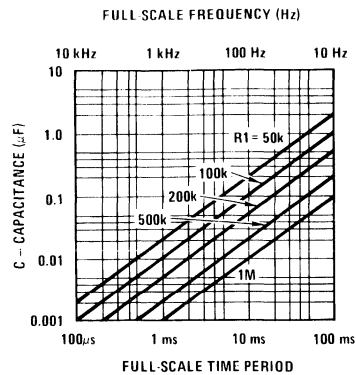


FIGURE 10. RC Selection Chart

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or visual warning of speeds in excess of that level. Many anti-pollution devices included on several recent automobile models have included a speed switch to disable the vacuum advance function until a certain speed is attained². A circuit which will perform these kind of functions is shown in *Figure 9*. A typical magnetic pickup for automotive applications will provide a thousand pulses per mile so that at 60 mph the incoming frequency will be 16.6 Hz. If the reference level on the comparator is set by two equal resistors R1 and R2 then the desired value of C1 and R1 can be determined from the simple relationship:

$$\frac{V_{CC}}{2} = V_{CC} \cdot C1 \cdot R1 \cdot f.$$

or $C1R1f = 0.5$
and hence $C1R1 = 0.03$

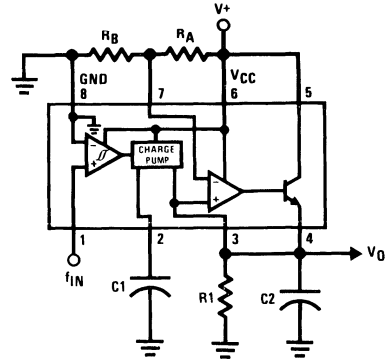
From the RC selection chart in *Figure 10* we can choose suitable values for R1 and C1. Examples are 100 kΩ and 0.3 μF. The circuit will then switch at approximately 60 mph with the stated input frequency relationship to speed. To determine the ripple voltage refer back to the equation for ripple voltage (under "Choosing R1, C1 and C2"). From this we can determine that there will be about 10 mV of ripple at the switching level. To prevent this from causing chattering of the load a certain amount of hysteresis is added by including R3. This will provide typically 1% of supply as a hysteresis or 1.2 mph in the example. Note that since the reference to the comparator is a function of supply voltage as is the output from the charge pump there is no need to regulate the power supply. The frequency at which switching occurs is independent of supply voltage.

In some industrial applications it is useful to have an indication of past speed excesses, for example in notifying the need for checking of bearings. The LM2907 can be made to latch until the power supply is turned "OFF" in the case where the frequency exceeds a certain limit, by simply connecting the output transistor emitter back to the non-inverting input of the comparator as shown in *Figure 11*. It can also serve to shut off a tape recorder or editing machine at the end of a rewind cycle. When the speed suddenly increases, the device will sense the condition and shut down the motor.

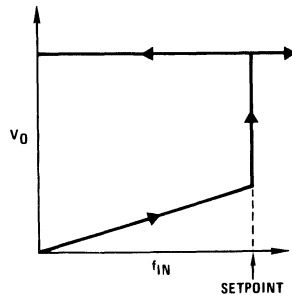
Analog Displays

The LM2907, LM2917 series devices are particularly useful for analog display of frequency inputs. In situations where the display device is a moving coil instrument the advantages of the uncommitted output transistor can be realized by providing a current drive to the meter. This avoids temperature tracking problems with the varying meter resistance and enables high resistance instruments to be driven accurately with relatively large voltages as illustrated in *Figure 12*. The LM2917 version is employed here to provide a regulated current to the instrument. The onboard 7.6V zener is compatible with car and boat batteries and enables the moving coil instrument to employ the full battery voltage for its deflection. This enables high torque meters to be used. This is particularly useful in high vibration environments such as boats and motorcycles. In the case of boats, the most common speed pickup for the knot meter employs a rotating propeller driving a magnetic pickup device. Meteorologists employ a large number of anemometers for measuring wind velocities and these are frequently coupled by a magnetic pickup. In examples like these, where there is frequently a large distance between the display device and the sensor, the configuration of *Figure 13* can be usefully employed to cut down on the number of wires needed. Here

the output current is conducted along the supply line so that a local current sensing device in the supply line can be used to get a direct reading of the frequency at the remote location where the electronics may also be situated. The small zero speed offset due to the device quiescent current may be compensated by offsetting the zero on the display device. This also permits one display device to be shared between several inputs.



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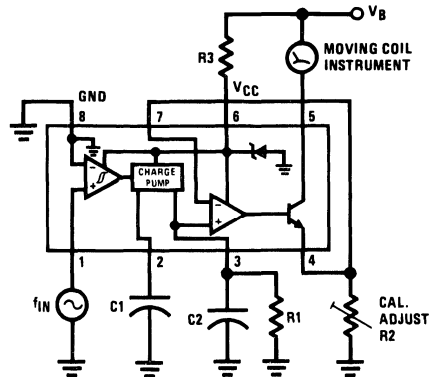
TL/H/7451-27

$$\left. \begin{aligned} V_O &= F_{IN}V + R1 C1 \\ \text{SETPOINT} &= V + \frac{RB}{RD + RA} \end{aligned} \right\} \text{Latchup occurs when}$$

$$F_{IN} = \frac{RB}{RA + RB} \frac{1}{R1 C1}$$

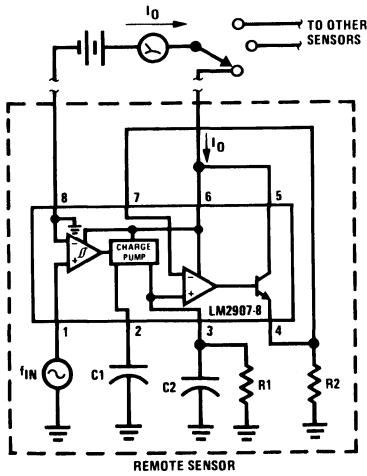
Independent of V + I

FIGURE 11. Overspeed Latch

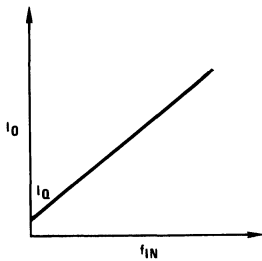


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FIGURE 12. Analog Display of Frequency



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TL/H/7451-30

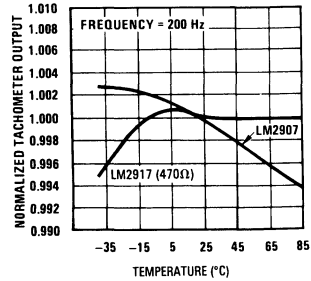
FIGURE 13. Two Wire Remote Speed Sensor

Automotive Tachometer

Not all inputs are derived from variable reluctance magnetic pickups; for example, in spark ignition engines the tachometer is generally driven from the spark coil. An interface circuit for this situation is shown in Figure 14. This tachometer can be set up for any number of cylinders by linking the appropriate timing resistor as illustrated. A 500Ω trim resistor can be used to set up final calibration. A protection circuit composed of a 10Ω resistor and a zener diode is also shown as a safety precaution against the transients which are to be found in automobiles.

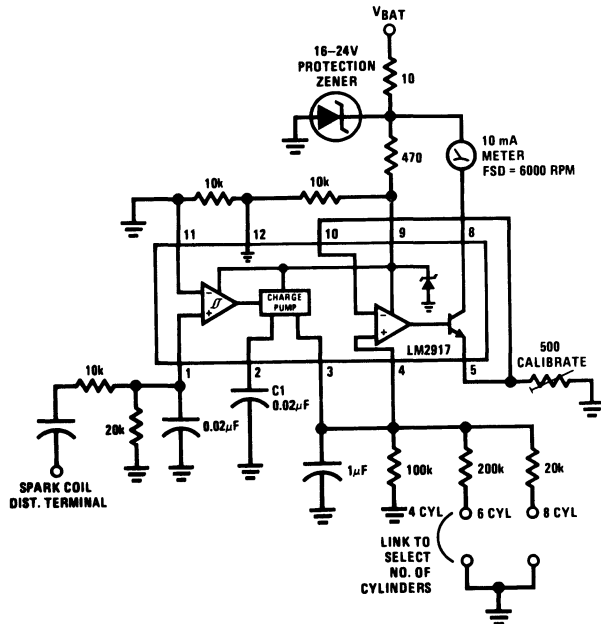
Motor Speed Controls

DC motors with or without brushes can be purchased with ac tachometer outputs already provided by the manufacturer³. With these motors in combination with the



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FIGURE 15. Normalized Tachometer Output vs. Temperature



TL/H/7451-31

FIGURE 14. Gasoline Engine Tachometer

LM2907, a very low cost speed control can be constructed. In *Figure 16* the most simple version is illustrated where the tachometer drives the non-inverting input of the comparator up towards the preset reference level. When that level is reached, the output is turned off and the power is removed from the motor. As the motor slows down, the voltage from the charge pump output falls and power is restored. Thus speed is maintained by operating the motor in a switching mode. Hysteresis can be provided to control the rate of switching. An alternative approach which gives proportional control is shown in *Figure 17*. Here the charge pump integrator is shown in a feedback connection around the operational amplifier. The output voltage for zero speed is equal to the reference voltage set up on the potentiometer on

the non-inverting input. As speed increases, the charge pump puts charge into capacitor C2 and causes the output V_{OUT} to fall in proportion to speed. The output current of the op amp transistor is used to provide an analog drive to the motor. Thus as the motor speed approaches the reference level, the current is proportionately reduced to the motor so that the motor gradually comes up to speed and is maintained without operating the motor in a switching mode. This is particularly useful in situations where the electrical noise generated by the switching mode operation is objectionable. This circuit has one primary disadvantage in that it has poor load regulation. A third configuration is shown in *Figure 18*. This employs an LM2907-8 acting as a shunt mode regulator. It also features an LED to indicate when the device is in regulation.

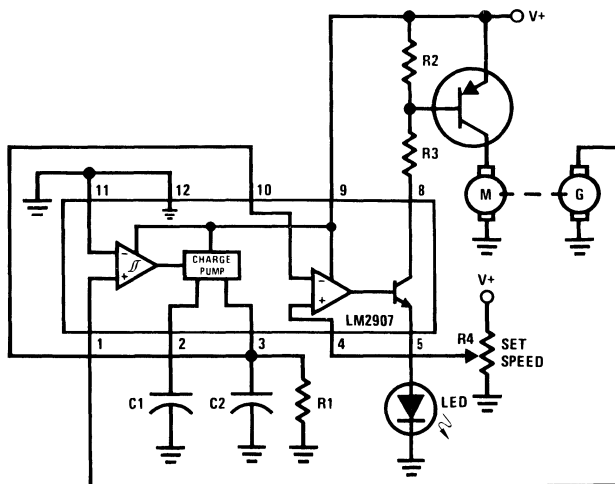


FIGURE 16. Motor Speed Control

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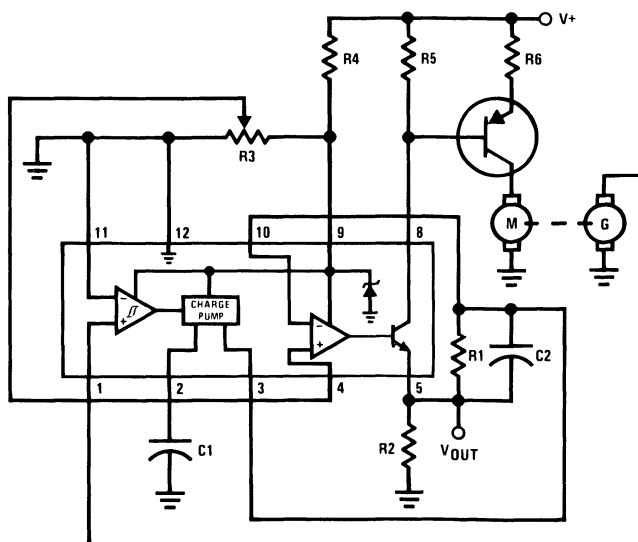


FIGURE 17. Motor Speed Control with Proportional Drive

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Position Sensing

In addition to their use to complete tachometer feedback loops, used in position transducer circuits, the LM2907, LM2917 devices can also be used as position transducers. For example, the timing resistor can be removed from pin 3 so that the output current produces a staircase instead of a fixed dc level. If the magnetic pickup senses passing notches or items, a staircase signal is generated which can then be compared with a reference to initiate a switching action when a specified count is reached. For example, *Figure 19* shows a circuit which will count up a hundred input pulses and then switch on the output stage. Examples of this application can be found in automated packaging operations or in line printers.

The output of the tachometer is proportional to the product of supply voltage, input frequency, a capacitor and a resistor. Any one of these may be used as the input variable or they may be used in combination to produce multiplication. An example of a capacitive transducer is illustrated in *Figure 20*, where a fixed input frequency is employed either from the 60 Hz line as a convenient source or from a stable oscillator. The capacitor is a variable element mechanically coupled to the system whose position is to be sensed. The output is proportional to the capacitance value, which can be arranged to have any desired relationship to the mechanical input by suitable shaping of the capacitor electrodes.

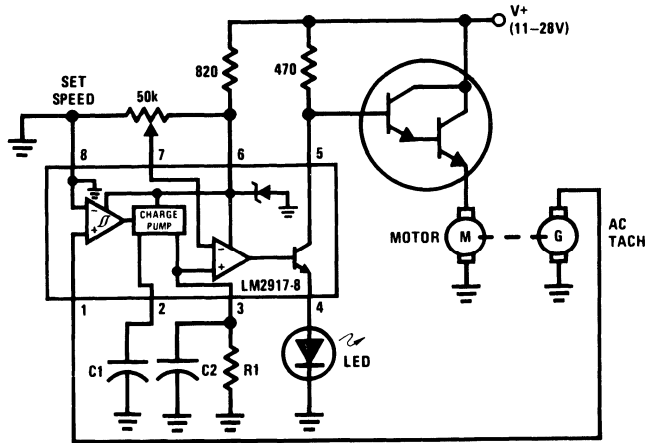
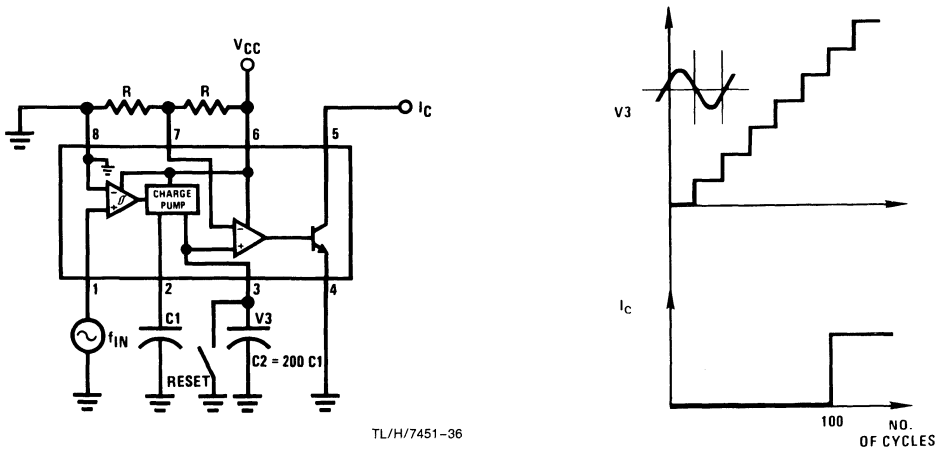


FIGURE 18. Motor Speed Control

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FIGURE 19. Staircase Counter

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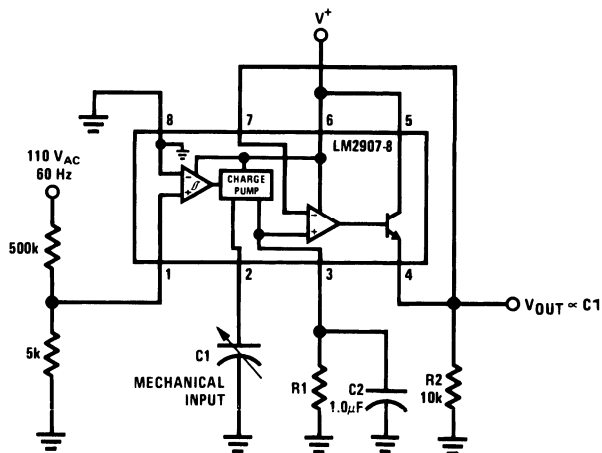


FIGURE 20. Capacitive Transducer

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Analog Systems Building Block

The LM2907, LM2917 series characterize systems building block applications by the feature that the output from the device is proportional only to externally programmed inputs. Any or all of these inputs may be controlled inputs to provide the desired output. For example, in Figure 20 the capacitance transducer can be operated as a multiplier. In flow measurement indicators, the input frequency can be a variable depending on the flow rate, such as a signal generated from a paddle wheel, propeller or vortex sensor⁴. The capacitor can be an indication of orifice size or aperture size, such as in a throttle body. The product of these two will indicate volume flow. A thermistor could be added to R1 to convert the volume flow to mass flow. So a combination of these inputs, including control voltage on the supply, can be used to provide complex multiplicative analog functions with independent control of the variables.

Phase-locked loops (PLL) are popular today now that low cost monolithic implementations are available off the shelf. One of their limitations is the narrow capture range and hold-in range. The LM2907 can be employed as a PLL helper. The configuration is shown in Figure 21. The LM2907 here serves the function of a frequency-to-voltage converter which puts the VCO initially at approximately the right frequency to match the input frequency. The phase detector is then used to close the gap between VCO and input frequency by exerting a control on the summing point. In this way, given proper tracking between the frequency-to-voltage converter and the VCO, (which is a voltage-to-frequency converter), a wide-range phase loop can be developed.

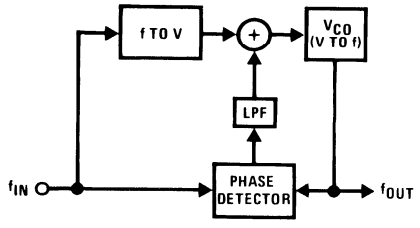


FIGURE 21. Phase-Locked Loop Helper
Added f to V Greatly Increases Capture and Hold Range

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The linearity of voltage controlled oscillators can be improved by employing the LM2907 as a feedback control element converting the frequency back to voltage and comparing with the input voltage. This can often be a lower cost solution to linearizing the VCO than by working directly on the VCO itself in the open loop mode. The arrangement is illustrated in Figure 22.

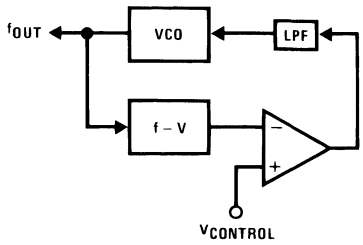


FIGURE 22. Feedback Controlled VCO

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Digital Interface

A growing proportion of the complex control systems today are being controlled by microprocessors and other digital devices. Frequently they require inputs to indicate position or time from some mechanical input. The LM2907 can be used to provide zero crossing datum to a digital system using the circuits illustrated in Figure 23. At each zero crossing of the input signal the charge pump changes the state of capacitor C1 and provides a one-shot pulse into the zener diode at pin 3. The width of this pulse is controlled by the internal current of pin 2 and the size of capacitor C1 as well as by the supply voltage. Since a pulse is generated by each zero crossing of the input signal we call this a "two-shot" instead of a "one-shot" device and this can be used for doubling the frequency that is presented to the microprocessor control system. If frequency doubling is not required and a square wave output is preferred, the circuit of Figure 24 can be employed. In this case, the output swing is the same as the swing on pin 2 which is a swing of half supply voltage starting at 1 V_{BE} below one quarter of supply and going to 1 V_{BE} below three-quarters of supply. This can be increased up to the full output swing capability by reducing or removing the negative feedback around the op amp.

The staircase generator shown in *Figure 19* can be used as an A-D converter. A suitable configuration is shown in *Figure 25*. To start a convert cycle the processor generates a reset pulse to discharge the integrating capacitor C2. Each complete clock cycle generates a charge and discharge cycle on C1. This results in two steps per cycle being added to C2. As the voltage on C2 increases, clock pulses are

turned to the processor. When the voltage on C2 steps above the analog input voltage the data line is clamped and C2 ceases to charge. The processor, by counting the number of clock pulses received after the reset pulse, is thus loaded with a digital measure of the input voltage. By making $C2/C1 = 1024$ an 8-bit A-D is obtained.

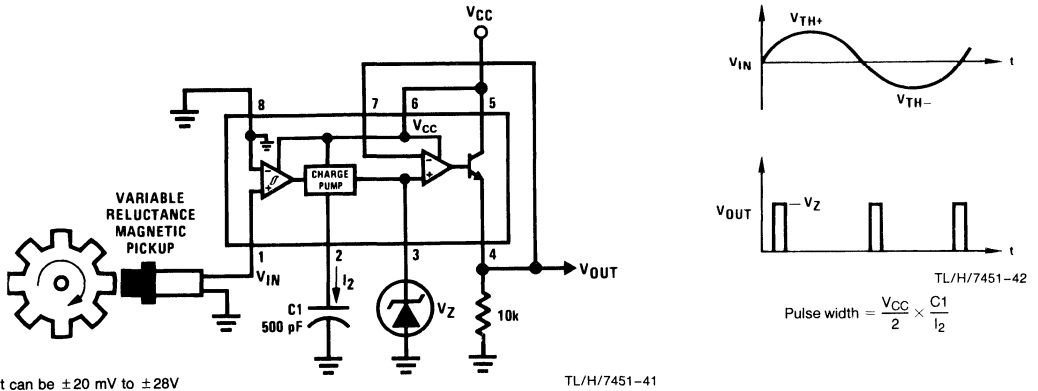


FIGURE 23. "Two-Shot" Zero Crossing Detector

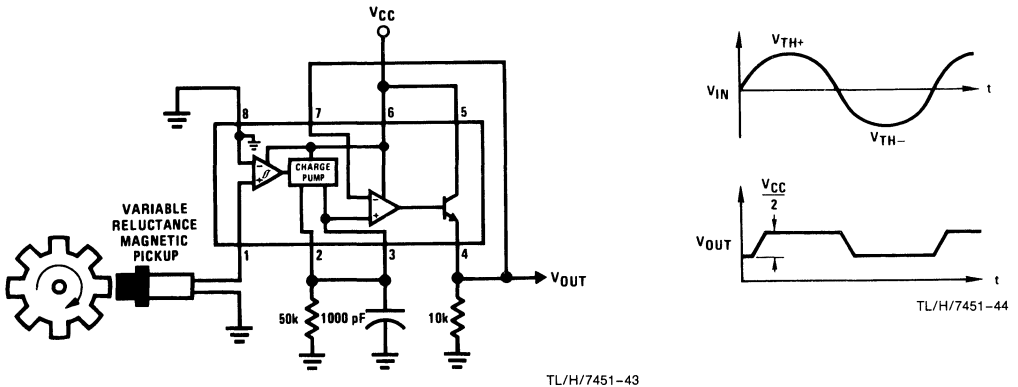


FIGURE 24. Zero Crossing Detector and Line Drivers

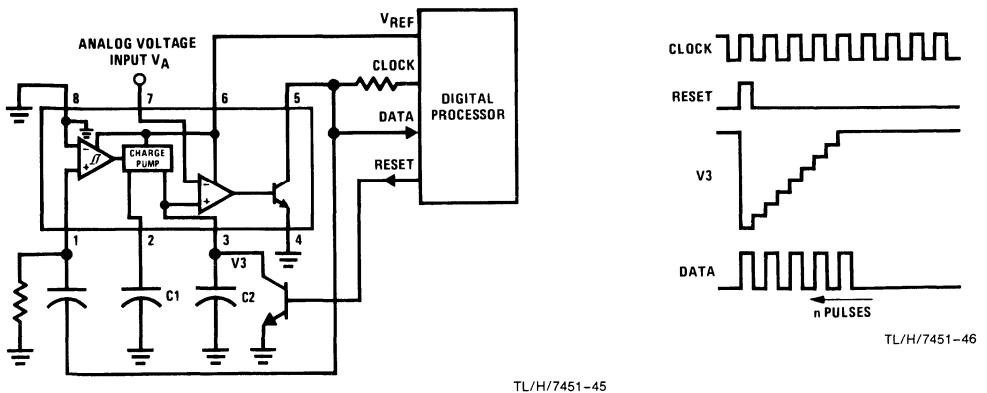
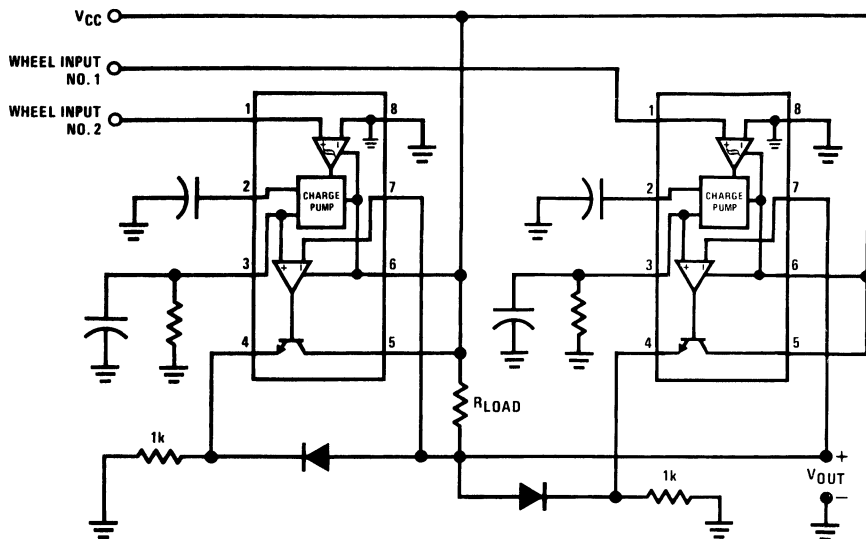


FIGURE 25. A-D Converter

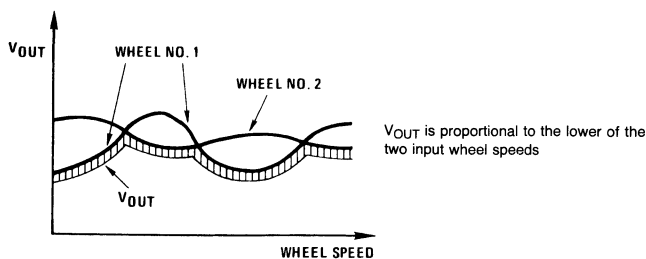
Anti-Skid Circuit Functions

Motor Vehicle Standards 121 place certain stopping requirements on heavy vehicles which require the use of electronic anti-skid control devices.⁵ These devices generally use variable reluctance magnetic pickup sensors on the wheels to provide inputs to a control module. One of the questions which the systems designer must answer is whether to use the average from each of the two wheels on a given axle or to use the lower of the two speeds or to use the higher of the two speeds. Each of the three functions can be generated by a single pair of LM2907-8 as illustrated in *Figures 26-28*. In *Figure 26* the input frequency from each wheel sensor is converted to a voltage in the normal manner. The op

amp/comparator is connected with negative feedback with a diode in the loop so that the amplifier can only pull down on the load and not pull up. In this way, the outputs from the two devices can be joined together and the output will be the lower of the two input speeds. In *Figure 27* the output emitter of the onboard op amp provides the pullup required to provide a select-high situation where the output is equal to the higher of two speeds. The select average circuit in *Figure 28* saves components by allowing the two charge pumps to operate into a single RC network. One of the amplifiers is needed then to buffer the output and provide a low impedance output which is the average of the two input frequencies. The second amplifier is available for other applications.

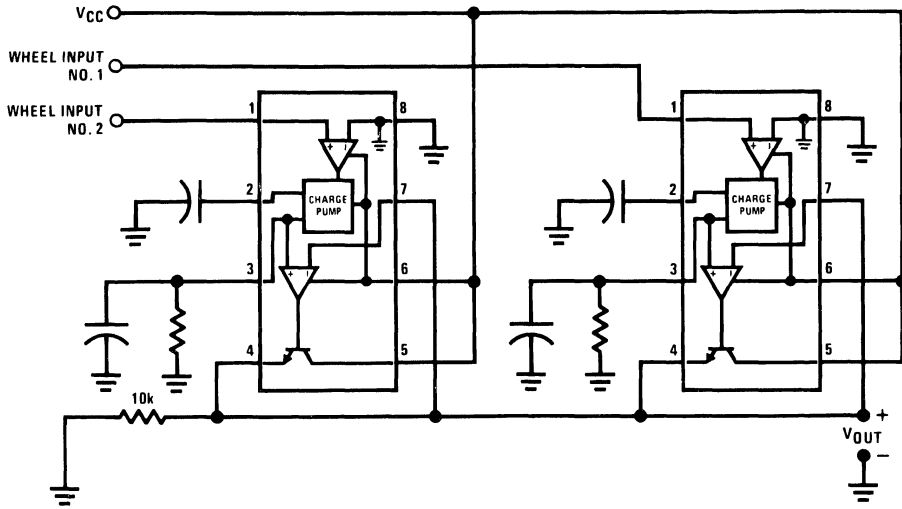


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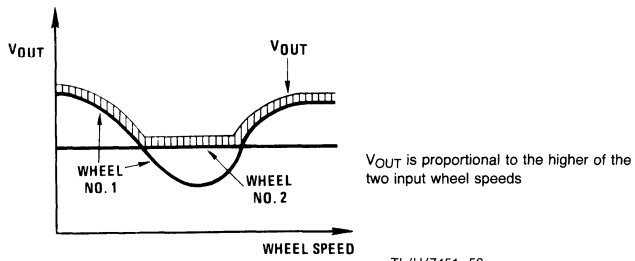


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FIGURE 26. "Select-Low" Circuit

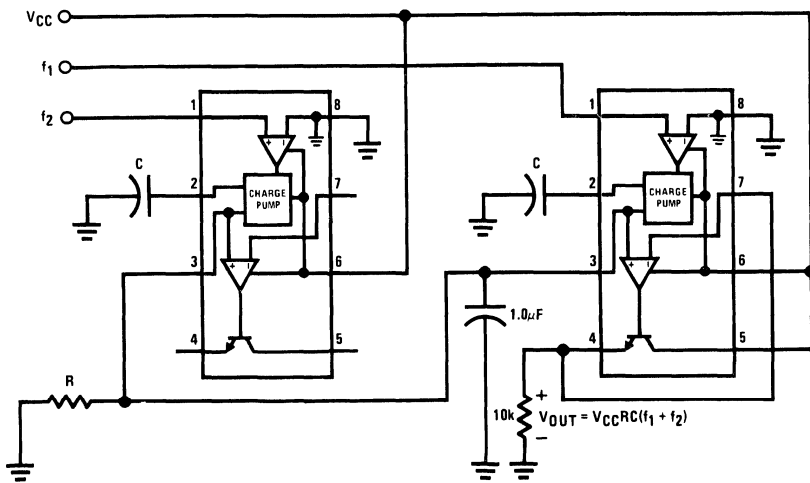


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TL/H/7451-50

FIGURE 27. "Select-High" Circuit



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FIGURE 28. "Select-Average" Circuit

Transmission and Clutch Control Functions

Electric clutches can be added to automotive transmissions to eliminate the 6% slip which typically occurs during cruise and which results in a 6% loss in fuel economy. These devices could be operated by a pair of LM2907's as illustrated in Figure 29. Magnetic pickups are connected to input and output shafts of the transmission respectively and provide frequency inputs f_1 and f_2 to the circuit. Frequency, f_2 , being the output shaft speed, is also a measure of vehicle road speed. Thus the LM2907-8 No. 2 provides a voltage proportional to road speed at pin 3. This is buffered by the op amp in LM2907-8 No. 1 to provide a speed output V_{OUT1} on pin 4. The input shaft provides charge pulses at the rate of $2f_1$ into the inverting node of op amp 2. This node has the integrating network R1, C3 going back to the output of the op amp so that the charge pulses are integrated and provide an inverted output voltage proportional to the input speed. Thus the output V_{OUT2} is proportional to the difference between the two input frequencies. With these two signals—the road speed and the difference between road speed and input shaft speed—it is possible to develop a number of control functions including the electronic clutch and a complete electronic transmission control. (In the configuration shown, it is not possible for V_{OUT2} to go below zero so that there is a limitation to the output swing in this direction. This may be overcome by returning R3 to a negative bias supply instead of to ground.)

CONCLUSION

The applications presented in this note indicate that the LM2907, LM2917 series devices offer a wide variety of uses ranging from very simple low cost frequency to voltage conversion to complex systems building blocks. It is hoped that the ideas contained here have given suggestions which may help provide new solutions to old problems. Additional applications ideas are included in the data sheet, which should be referred to for all specifications and characteristics.

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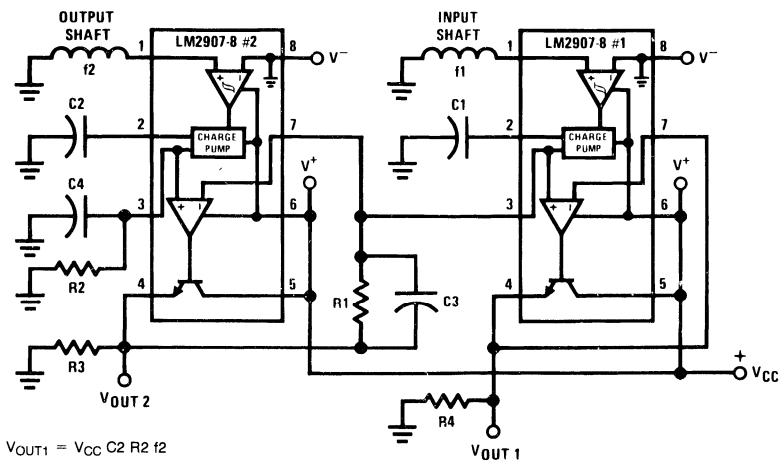


FIGURE 29. Transmission or Clutch Control Functions

TL/H/7451-52

IC Zener Eases Reference Design



DESCRIPTION

A new IC zener with low dynamic impedance and wide operating current range significantly simplifies reference or regulator circuit design. The low dynamic impedance provides better regulation against operating current changes, easing the requirements of the biasing supply. Further, the temperature coefficient is independent of operating current, so that the LM129 can be used at any convenient current level. Other characteristics such as temperature coefficient, noise and long term stability are equal to or better than good quality discrete zeners.

The LM129 uses a new subsurface breakdown IC zener combined with a buffer circuit to lower dynamic impedance. The new subsurface zener has low noise and excellent long term stability since the breakdown is in the bulk of the silicon. Circuitry around the zener supplies internal biasing currents and buffers external current changes from the zener. The overall breakdown is about 6.9V with devices selected for temperature coefficients.

The zener is relatively straightforward. A buried zener D1 breaks down biasing the base of transistor Q1. Transistor Q1 drives two buffers Q2 and Q3. External current changes through the circuit are fully absorbed by the buffer transistors rather than by D1. Current through D1 is held constant at 250 μ A by a 2k resistor across the emitter base of Q1 while the emitter-base voltage of Q1 nominally temperature compensates the reference voltage.

The other components, Q4, Q5 and Q6, set the operating current of Q1. Frequency compensation is accomplished with two junction capacitors.

All that is needed for biasing in most applications is a resistor as shown in *Figure 2*. Biasing current can be anywhere from 0.6 mA to 15 mA with little change in performance. Optimally, however, the biasing current should be as low as possible for the best regulation. The dynamic impedance of the LM129 is about 1 Ω and is independent of current. Therefore, the regulation of the LM129 against voltage changes is $1/R_s$.

Lower currents or higher R_s give better regulation. For example, with a 15V supply and 1 mA operating current, the reference change for a 10% change in the 15V supply is 180 μ V. If the LM129 is run at 5 mA, the change is 900 μ V or 5 times worse. By comparison, a standard IN821 zener will change about 17 mV. All discrete zeners have about the same regulation since their dynamic impedance is inversely proportional to operating current.

If the zener does not have to be grounded, a bridge compensating circuit can be used to get virtually perfect regulation, as shown in *Figure 3*. A small compensating voltage is generated across R_1 , which matches the dynamic impedance of the LM129. Since the dynamic impedance of the LM129 is linear with current, this circuit will work even with large changes in the unregulated input voltage.

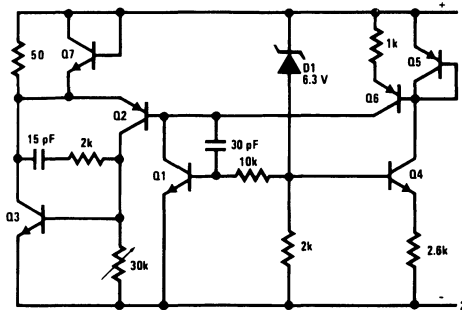


FIGURE 1. IC Reference Zener

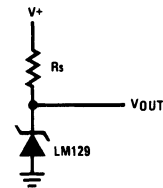


FIGURE 2. Basic Biasing

TL/H/5614-1

Other output voltages are easily obtained with the simple op-amp circuit shown in *Figure 4*. A simple non-inverting amplifier is used to boost and buffer the zener to 10V. The reference is run directly from the input power rather than the output of the op-amp. When the zener is powered from the op-amp, special starting circuitry is sometimes necessary to insure the output comes up in the right polarity. For outputs lower than the breakdown of the LM129 a divider can be connected across the zener to drive the op-amp.

An AC square wave or bipolarity output reference can easily be made with an op-amp and FET switch as shown in *Figure 5*. When Q1 is "ON", the LM108 functions as a normal inverting op-amp with a gain of -1 and an output of $-6.9V$. With Q1 "OFF" the op-amp acts as a giving 6.9 V at the output. Some non-symmetry will occur from loading change on the LM129 in the different states and mismatch of R1 and R2. Trimming either R1 or R2 can make the output exactly symmetrical around ground.

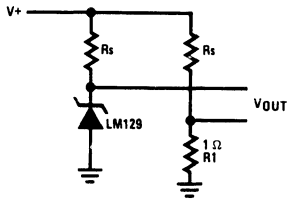


FIGURE 3. Bridge Compensation for Line Changes

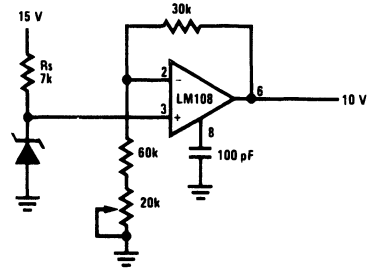


FIGURE 4. 10 Volt Buffered Output Reference

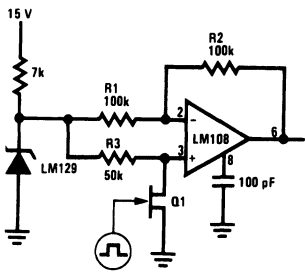


FIGURE 5. Bipolar Output Reference

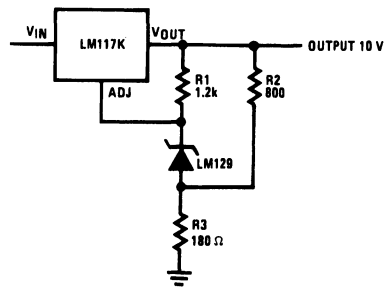


FIGURE 6. High Stability 10 V Regulator

TL/H/5614-2

By combining the LM129 with an LM117 three-terminal regulator a high stability power regulator can be made. This is shown in *Figure 6*. Resistor R1 biases the LM129 at about 1 mA from the 1.25V reference in the LM117. The voltage of the LM129 is added to the 1.25V of the LM117 to make a total reference voltage of 8.1V. The output voltage is then set at 10V by R2 and R3. Since the internal reference of the LM117 contributes only about 20% of the total reference voltage, regulation and drift are essentially those of the external zener. The regulator has 0.2% load and line regulation and if a low drift zener such as the LM129A is used overall temperature coefficient is less than 0.002%/°C.

The new zener can be used as the reference for conventional IC voltage regulators for enhanced performance. Noise is lower, time stability is better, and temperature coefficient can be better depending on the device selected. Further, the output voltage is independent of power changes in the regulator.

Figure 7 shows an LM723 using an external LM129 reference. The internal 7V reference is not used and a single resistor biases the LM129 as the reference. The 5k resistor chosen provides sufficient operating current for the zener over the 10V to 40V input voltage range of the LM723. Since the dynamic impedance of the LM129 is so low, the reference regulation against line changes is only 0.02%/V. This is small compared to the regulation of 0.1%/V for the LM723; however, the resistor can be replaced by a 1 mA to 5 mA FET used as a constant current source for improved

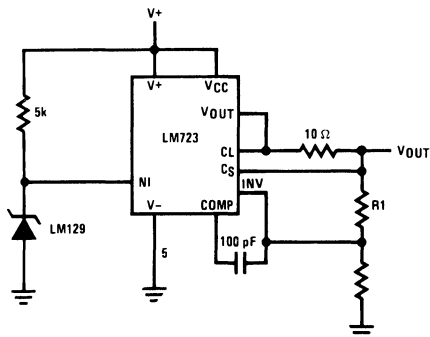


FIGURE 7. External Reference For IC

regulation. When the FET is used reference regulation is easily 0.001%/V. Output voltage is set in the standard manner except that for low output voltages sufficient current must be run through the zener to power the voltage divider supplying the reference to the LM723.

An overload protected power shunt regulator is shown in *Figure 8*. The output voltage is about 7.8V — the 7V breakdown of the LM129 plus the 0.8V emitter-base voltage of the LM395. The LM395 is an IC, 1.5 A power transistor with complete overload protection on the chip. Included on the chip are current limiting and thermal limiting, making the device virtually blowout-proof. Further, the base current is only 5 μ A, making it easy to drive as a shunt regulator. As the input voltage rises, more drive is applied to the base of the LM395, turning it on harder and dropping more voltage across the series resistance. Should the input voltage rise too high, the LM395 will current limit or thermal limit, protecting itself.

The new IC zener can replace existing zeners in just about any application with improved performance and simpler external circuitry. As with any zener reference, devices are selected for temperature coefficient and operating temperature range. Since the devices are made by a standard integrated circuit process, cost is low and good reproducibility is obtained in volume production.

Finally, since the device is actually an IC, it is packaged in a rugged TO-46 metal can package or a 3-lead plastic transistor package.

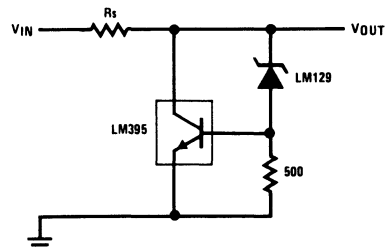


FIGURE 8. Power Shunt Regulator

TL/H/5614-3

Applications for an Adjustable IC Power Regulator

National Semiconductor
Application Note 178



AN-178

A new 3-terminal adjustable IC power regulator solves many of the problems associated with older, fixed regulators. The LM117, a 1.5A IC regulator is adjustable from 1.2V to 40V with only 2 external resistors. Further, improvements are made in performance over older regulators. Load and line regulation are a factor of 10 better than previous regulators. Input voltage range is increased to 40V and output characteristics are fully specified for load of 1.5A. Reliability is improved by new overload protection circuitry as well as 100% burn-in of all parts. The table below summarizes the typical performance of the LM117.

TABLE I

Output Voltage Range	1.25V–40V
Line Regulation	0.01%/V
Load Regulation $I_L = 1.5A$	0.1%
Reference Voltage	1.25V
Adjustment Pin Current	50 μA
Minimum Load Current (Quiescent Current)	3.5 mA
Temperature Stability	0.01%/°C
Current Limit	2.2A
Ripple Rejection	80 dB

The overload protection circuitry on the LM117 includes current limiting, safe-area protection for the internal power transistor and thermal limiting. The current limit is set at 2.2A and, unlike presently available positive regulators, remains relatively constant with temperature. Over a $-55^\circ C$ to

$+150^\circ C$ temperature range, the current limit only shifts about 10%.

At high input-to-output voltage differentials the safe-area protection decreases the current limit. With the LM117, full output current is available to 15V differential and, even at 40V, about 400 mA is available. With some regulators, the output will shut completely off when the input-to-output differential goes above 30V, possibly causing start-up problems. Finally, the thermal limiting is always active and will protect the device even if the adjustment terminal should become accidentally disconnected.

Since the LM117 is a floating voltage regulator, it sees only the input-to-output voltage differential. This is of benefit, especially at high output voltage. For example, a 30V regulator nominally operating with a 38V input can have 70V input transient before the 40V input-to-output rating of the LM117 is exceeded.

BASIC OPERATION

The operation of how a 3-terminal regulator is adjusted can be easily understood by referring to *Figure 1*, which shows a functional circuit. An op amp, connected as a unity gain buffer, drives a power Darlington. The op amp and biasing circuitry for the regulator is arranged so that all the quiescent current is delivered to the regulator output (rather than ground) eliminating the need for a separate ground terminal. Further, all the circuitry is designed to operate over the 2V to 40V input-to-output differential of the regulator.

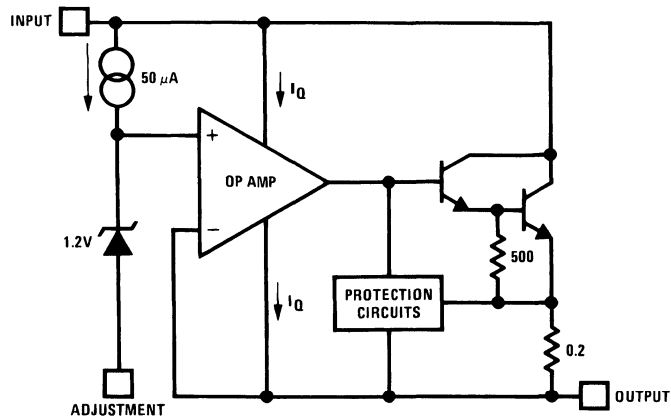


FIGURE 1. Functional Schematic of the LM117

TL/H/7334-1

A 1.2V reference voltage appears inserted between the non-inverting input of the op amp and the adjustment terminal. About 50 μA is needed to bias the reference and this current comes out of the adjustment terminal. In operation, the output of the regulator is the voltage of the adjustment terminal plus 1.2V. If the adjustment terminal is grounded, the device acts as a 1.2V regulator. For higher output voltages, a divider R1 and R2 is connected from the output to ground as is shown in *Figure 2*. The 1.2V reference across resistor R1 forces 10 mA of current to flow. This 10 mA then flows through R2, increasing the voltage at the adjustment terminal and therefore the output voltage. The output voltage is given by:

$$V_{\text{OUT}} = 1.2\text{V} \times \left(1 + \frac{R_2}{R_1} \right) + 50 \mu\text{A} R_2$$

The 50 μA biasing current is small compared to 5 mA and causes only a small error in actual output voltages. Further, it is extremely well regulated against line voltage or load current changes so that it contributes virtually no error to dynamic regulation. Of course, programming currents other than 10 mA can be used depending upon the application.

Since the regulator is floating, all the quiescent current must be absorbed by the load. With too light of a load, regulation is impaired. Usually, a 5 mA programming current is sufficient; however, worst case minimum load for commercial grade parts requires a minimum load of 10 mA. The minimum load current can be compared to the quiescent current of standard regulators.

APPLICATIONS

An adjustable lab regulator using the LM117 is shown in *Figure 2* and has a 1.2V to 25V output range. A 10 mA program current is set by R1 while the output voltage is set by R2. Capacitor C1 is optional to improve ripple rejection so that 80 dB is obtained at any output voltage. The diode, although not necessary in this circuit since the output is limited to 25V, is needed with outputs over 25V to protect against the capacitors discharging through low current nodes in the LM117 when the input or output is shorted.

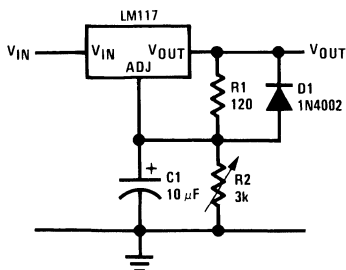


FIGURE 2. Basic Voltage Regulator

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The programming current is constant and can be used to bias other circuitry, while the regulator is used as the power supply for the system. In *Figure 3*, the LM117 is used as a 15V regulator while the programming current powers an LM127 zener reference. The LM129 is an IC zener with less than 1 Ω dynamic impedance and can operate over a range of 0.5 mA to 15 mA with virtually no change in performance.

Another example of using the programming current is shown in *Figure 4* where the output setting resistor is tapped to provide multiple output voltage to op amp buffers. An additional transistor is included as part of the overload protection. When any of the outputs are shorted, the op amp will current limit and a voltage will be developed across its inputs. This will turn "ON" the transistor and pull down the adjustment terminal of the LM117, causing all outputs to decrease, minimizing possible damage to the rest of the circuitry.

Ordinary 3-terminal regulators are not especially attractive for use as precision current regulators. Firstly, the quiescent current can be as high as 10 mA, giving at least 1% error at 1A output currents, and more error at lower currents. Secondly, at least 7V is needed to operate the device. With the LM117, the only error current is 50 μA from the adjustment terminal, and only 4.2V is needed for operation at 1.5A or 3.2V at 0.5A. A simple 2-terminal current regulator is shown in *Figure 5* and is usable anywhere from 10 mA to 1.5A.

Figure 6 shows an adjustable current regulator in conjunction with the voltage regulator from *Figure 2* to make constant voltage/constant current lab-type supply. Current sensing is done across R1, a 1 Ω resistor, while R2 sets the current limit point. When the wiper of R2 is connected, the 1 Ω sense resistor current is regulated at 1.2A. As R2 is adjusted, a portion of the 1.2V reference of the LM117 is cancelled by the drop across the pot, decreasing the current limit point. At low output currents, current regulation is degraded since the voltage across the 1 Ω sensing resistor becomes quite low. For example, with 50 mA output current, only 50 mV is dropped across the sense resistor and the supply rejection of the LM117 will limit the current regulation

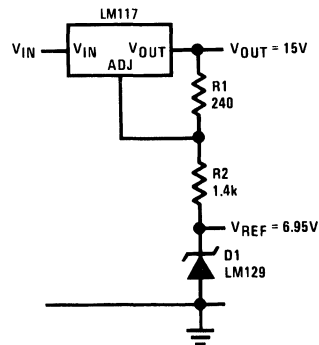


FIGURE 3. Regulator and Voltage Reference

TL/H/7334-3

to about 3% for a 40V change across the device. An alternate current regulator is shown in *Figure 7* using an additional LM117 to provide the reference, rather than an LM113 diode. Both current regulators need a negative supply to operate down to ground.

Figure 8 shows a 2-wire current transmitter with 10 mA to 50 mA output current for a 1V input. An LM117 is biased as a 10 mA current source to set the minimum current and provide operating current for the control circuitry. Operating

off the 10 mA is an LM108 and an LM129 zener. The zener provides a common-mode voltage for operation of the LM108 as well as a 6.9V reference, if needed. Input signals are impressed across R3, and the current through R3 is delivered to the output of the regulator by Q1 and Q2. For a 25Ω resistor, this gives a 40 mA current change for a 1V input. This circuit can be used in 4 mA to 20 mA applications, but the LM117 must be selected for low quiescent current. Minimum operating voltage is about 12V.

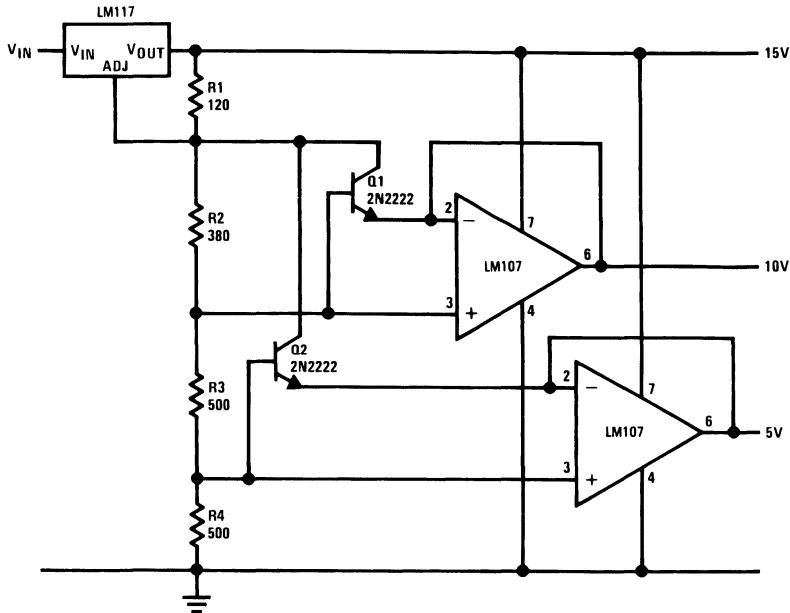
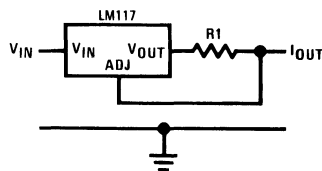


FIGURE 4. Regulator with Multiple Outputs

TL/H/7334-4



$$I_{OUT} = \frac{1.25V}{R1}$$

$$10\text{ mA} \leq I_{OUT} \leq 1.5A$$

TL/H/7334-5

FIGURE 5. 2-Terminal Current Regulator

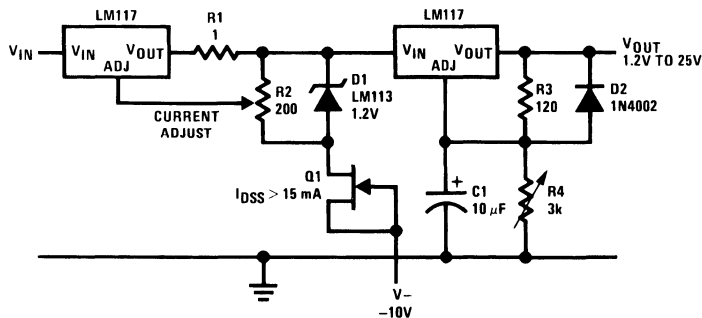
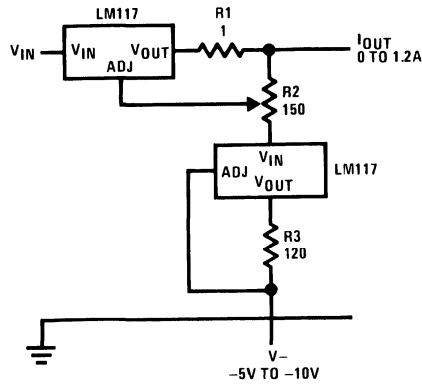


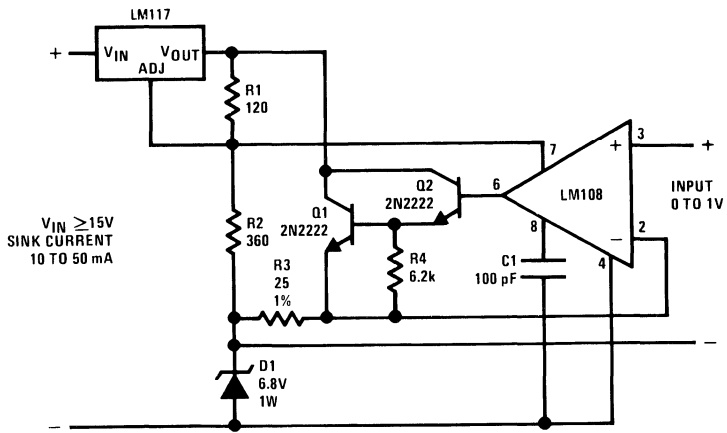
FIGURE 6. Adjustable Regulator. Constant Voltage/Constant Current, 10 mA to 1.2A

TL/H/7334-6



TL/H/7334-7

FIGURE 7. Adjustable Current Regulator



TL/H/7334-8

FIGURE 8. 10 mA to 50 mA 2-Wire Current Transmitter

RMS Converters and Their Applications

National Semiconductor
Application Note 180
John T. Lee
Hybrid Special Products



INTRODUCTION

A true RMS converter is a device which converts a signal (DC, AC, AC + DC) to its equivalent DC heating value. These devices are useful in fundamental measurements of virtually all waveforms.

SOME BASICS ABOUT RMS CONVERTERS

I. What is the RMS Value of a Waveform?

The Root Mean Squared (RMS) value of a waveform is a fundamental measurement of that waveform: it is a measure of the waveform's heating value when applied to a resistor.

A fundamental theory of Fourier Analysis states that any periodic function may be represented in a trigonometric series. This series is sum of sinusoidal components having different frequencies and amplitudes. These components are all multiples of the fundamental frequency. Thus, for a periodic function, the power content (also its mean-squared value) in the period T is defined to be:

$$\text{mean square value} = \frac{1}{T} \int_{-T/2}^{T/2} [f(t)]^2 dt = \sum_{n=-\infty}^{\infty} |C_n|^2$$

where the C_n s are the complex Fourier coefficients of the function. It is seen that if $f(t)$ is a voltage or a current waveform, then the mean square value represents the average power delivered by $f(t)$ to a 1Ω resistor. Summing its discrete components, one can obtain the power content of the signal. A graph of these components vs frequency is known as a power spectral density plot.

The RMS value is defined to be:

$$\text{RMS} = \sqrt{\frac{1}{T} \int_0^T [f(t)]^2 dt}$$

Thus, one can see that the RMS value is just the square root of the mean square value.

Since the mean square value of a periodic function is the sum of the mean square value of its discrete harmonics (without regard to their phases) it is seen that any signal with the same mean square value (thus RMS value) will dissipate the same amount of energy, over a period, in a resistor.

Whereas periodic signals may be completely described by their amplitudes, phases, and frequencies, random signals are those where future behavior cannot be predicted. Random signals may only be described by quantities such as the RMS value, power spectral density, and probability distribution. If for a random signal there exists a statistical value such as the RMS that is independent of time, then this signal is said to be stationary. The RMS value of any stationary zero mean random signal is equal to the standard deviation of the signal.

Whereas periodic signals have a discrete power density spectrum, random signals have a continuous spectrum. The RMS value of a random signal may be defined to be:

$$\text{RMS} = \sqrt{\lim_{T \rightarrow \infty} \frac{1}{T} \int_0^T f(t)^2 dt}$$

For a random signal, then, it is necessary to break the signal up into many narrow bands in order to investigate its power spectral density.

II. Why RMS Converters? Why Not Average Detect?

Since the mean square value (hence RMS) measures the power content of a signal, it provides a universal scale of measurement. An RMS measurement will give the intensity of a random phenomenon when averaged over a time interval. Besides periodic signals, phenomena such as acoustic noise, electrical noise, and mechanical vibration may be characterized. It is seen that instruments that read RMS values would be highly desirable.

Until recently, due to the high cost of RMS converters, most AC voltmeters did not read the RMS value of a waveform. Instead, they were average reading and RMS calibrated. This is done by taking the Mean Averaged Value (MAV) and multiplying by a factor of 1.11. This calibration is accurate only for measuring sinewaves. However, if the signal is not a pure sinewave, this type of instrument could lead to great errors. For example, such meters would read about 11% low on gaussian noise and about 11% high on symmetrical square waves. Note that if one knew beforehand that the waveform to be measured consisted of symmetrical square waves the meter could be calibrated accordingly. However, this meter would hardly be useful for anything else. Also, since many signals may change waveform during measurement, it would be impossible to try to calibrate the meter.

An example of a varying waveform would be the output of a ferroresonant line voltage regulator. The waveform could change from a sinewave to a square wave; when the output is a sinewave the average type meter would read correctly, however when the output is a square wave the meter would read in error of as much as 11%.

Another example would be the voltage from an SCR controlled circuit. An averaging meter would read correctly only during 180° conduction angle; it would read in error of 51% at 45° conduction angle.

Yet another example would be the output of an audio system during intermodulation testing. The true RMS value is insensitive to the ratio of frequencies, while the average value is highly sensitive to this ratio. Table I compares normalized readings between RMS and average detecting type meters. It is seen that whenever a waveform other than sinusoidal is to be measured, an RMS type meter should be used.

TABLE I. Comparison of RMS & AVG Detecting Type Meters

Waveform		RMS	AVG
Sine		1	1
SCR Cond Angle	180°	1	1
	90°	0.707	0.5
	45°	0.301	0.15
Gaussian Noise		δ^*	$0.89\delta^*$
Zero Based	10% duty cycle	$A/\sqrt{10}$	$A/10$
Pulse Train	1% duty cycle	$A/10$	$A/100$

* δ = standard deviation = RMS value

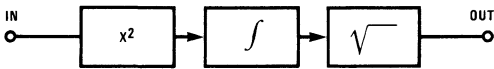
III. What Kinds of RMS Converters Are There?

There are basically three methods of RMS measurements:

- 1. Thermal.** This method is achieved by converting an unknown voltage or current into heat in a known value of resistance.
- 2. Direct Computing.** From the definition of RMS,

$$RMS = \sqrt{\frac{1}{T} \int_0^T f(t)^2 dt}$$

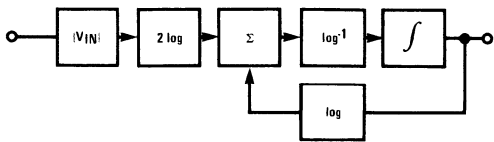
we can see that the RMS value may be determined by first squaring the waveform, then averaging it, and then taking the square root. This method is illustrated in Figure 1.



TL/H/8747-1

FIGURE 1. Direct Computing Type RMS Converter

- 3. Implicit Computing.** This scheme is similar to the second one with the square root performed by feedback and the squaring done by log method. This method is illustrated in Figure 2.



TL/H/8747-2

FIGURE 2. Implicit Computing Type RMS Converter

Of the three methods mentioned above, the Implicit Computing method is by far the most desirable—since a converter of this type can achieve great accuracy, wide bandwidth, high dynamic range, and low cost. The LH0091, National Semiconductor's true RMS converter, is such a unit.

SPECIFICATIONS

An ideal RMS converter would have infinite crest factor response, infinite bandwidth, and no errors due to conversion. Since this is not yet an ideal world, the performance of a practical converter will be discussed.

A practical converter should have sufficient bandwidth to respond to the entire spectrum of the measured signal; it should also have adequate crest factor response and accuracy to meet the particular application. Thus, these are important characteristics of an RMS converter.

- 1. Crest Factor.** Crest Factor is the peak signal value divided by the RMS value. In general, the higher the crest factor a signal has, the higher the conversion error will be for a converter. This is due to internal circuit limitations. However, most signals encountered in measurement do not have high crest factors. For example, sinewaves have a crest factor of 1.414; triangular waves have CF of 1.73; for an SCR output, the CF varies from 1.414 to 3 as power output varies from 100% to 10%. One of the few waveforms which has high crest factor is noise; however, the crest factor of common noise is 3 or less for 99.7% of the time. The probability of a gaussian noise having a crest factor greater than 4 is 0.01%.

A zero based pulse train is one of the rare waveforms which can have very high crest factors; such a pulse train with a 1% duty cycle will have a crest factor of ten. Using the high crest factor connection, the LH0091 will respond to signals with crest factor of 10 with typically no more than 0.2% error.

- 2. Accuracy.** The accuracy of a converter is in reality its conversion error. Error is the amount by which the actual DC output differs from the theoretical value. It is customary to define error as a sum of a fixed offset term and a percent of reading term. For the LH0091, both the unadjusted and the adjusted total errors are specified; they are 20 mV \pm 0.5% and 0.5 mV \pm 0.05% respectively.
- 3. Frequency Response.** The frequency response of a computing type RMS converter has an upper and a lower bound; on the low frequency end, it depends on the size of averaging capacitor; on the high frequency end, it depends on internal circuitry. Since this type of converter uses an RC filter for averaging, the RC time constant is critical for low frequency response. The RC time constant should be much greater (10 times or more) than the period of the lowest frequency component of the signal. For the LH0091, the RC time constant is simply the product of a 10 k Ω resistor and the external capacitor. Low leakage capacitors should be chosen.
- 4. Frequency for Specified Adjusted Error.** This is the frequency below which the output will maintain the adjusted accuracy (specified for sinewaves). For the LH0091, the device will maintain the adjusted accuracy to 70 kHz, typically, for a 7 Vrms input.

- 5. Frequency for 1% Additional Error.** This is the frequency below which the device will have an additional error of less than 1% of the initial reading (midband). This is also specified for sinewaves. This frequency is typically 200 kHz for a 7 Vrms input with the LH0091.

APPLICATIONS

RMS converters may be used in measurement of virtually any waveform. The examples below are only a few of the many possible applications.

A. Spectrum Analysis

Spectrum analysis is useful in characterizing random phenomena, identifying sources of mechanical vibration and noise. It is also used in characterizing the energy content of a signal. The RMS converter may be used in such an application.

As shown in *Figure 3*, the signal is passed through a tunable bandpass filter, and then it is read by the RMS converter. The output from the RMS converter represents the energy content in the narrow band of frequencies. If this procedure were repeated many times (each time changing the center frequency of the filter) we would have the power spectral density of the signal.

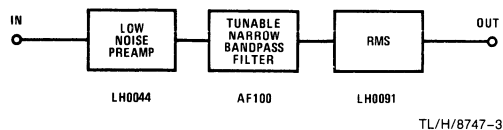


FIGURE 3. Application of the RMS Converter in Spectrum Analysis

B. Total Harmonic Distortion Meter

A simple and low cost total % harmonic distortion meter is shown in *Figure 4*.

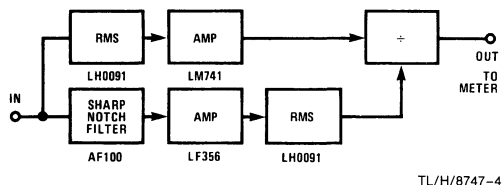


FIGURE 4. Total Distortion Meter

It is seen that the amplitude of the signal from which the fundamental has been rejected is divided by the amplitude of the composite signal; thus the output is a measure of total harmonic distortion.

C. Noise Meter

A complete noise meter is shown in *Figure 5*. Note that this meter will indicate the total noise within the frequency band of interest. However, if a tunable filter were added, one could plot the noise spectrum of the environment, thus being able to identify the sources of noise.

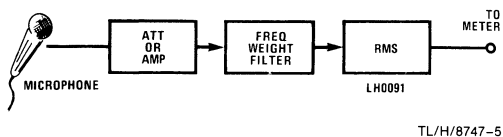


FIGURE 5. Noise Meter

D. Current Measurement

A current meter capable of measuring complex current waveforms is shown in *Figure 6*. Note that since the RMS converter is used, virtually any current waveform may be measured. Examples of such current waveforms are pulse train, SCR, and noise.

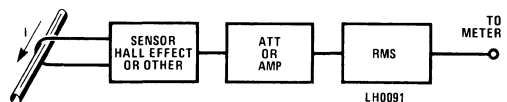


FIGURE 6. Current Meter

E. DVM AC Interface

Another application of the RMS converter would be an AC interface to a DVM. With such an interface, a DVM may be used to measure complex signals. Since most computing type RMS converters have relatively low input impedance, a buffer should be added as shown in *Figure 7*.

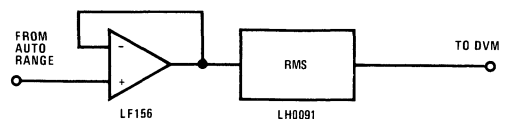


FIGURE 7. DVM AC Interface

F. Random Vibration and Noise

Random phenomena, such as random vibration and electrical noise, may be described only by such quantities as RMS, power spectral density, and probability distribution of magnitudes.

The spectral density of a wide band random signal is defined to be the mean square value of the signal per unit bandwidth. It is seen that we can obtain a kind of spectral density by dividing the RMS value (band limited) by the square root of the noise bandwidth, where:

$$\text{noise} = E/\sqrt{\Delta f} \text{ volts/Hz}^{1/2}$$

The result can be interpreted as simply the RMS noise voltage in 1 Hz of bandwidth. Thus wideband electrical noise may be measured as shown in *Figure 8*. If the filter in *Figure 8* is tunable, then it would be possible to plot the spectral density of the signal.

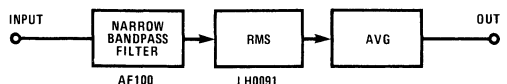


FIGURE 8. Measurement of Noise

For random mechanical vibrations, an accelerometer and a preamp are added to the circuit. This is shown in *Figure 9*.



FIGURE 9. Application of the RMS Converter in Random Vibration

G. Ball Bearing and Other Vibrational Failure Monitor

A very interesting application of the RMS converter is in the monitoring of ball bearing and other vibrational failure. A discussion is given on the ball bearing, but the principle is applicable to any vibrational monitors.

It has been found* that a knowledge of bearing geometry is sufficient to enable the prediction of frequency of fault-induced vibration. There are natural frequency formulas relating directly to bearing geometry. When vibration is generated by impact due to defects, the impact frequencies are usually much lower than the natural frequency of the outer bearing race. Thus the natural frequencies are brought to life. An example of this would be a ball of 200 Hz natural frequency being struck several times a second: the corresponding plot of the oscillation would tend to exhibit 200 Hz and ignore the striking frequency.

It is possible to monitor the fundamental frequency of the outer race. However, it may be necessary to monitor a band of frequencies, depending on the application. If an RMS reading is taken to detect the normal operation level of a new bearing (after a few hours of operation) a safe level may now be set. Thereafter, if the RMS level exceeds the set safe level, an alarm could be triggered. A circuit for such a function is shown in *Figure 10*. If the bandpass filter is tunable, diagnosis of the failure can be performed.

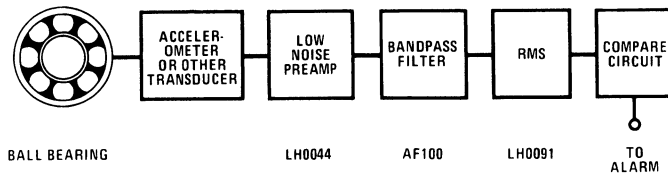


FIGURE 10. Ball Bearing Failure Monitor

TL/H/8747-10

*See *Vibration & Acoustic Measurement Handbook*, Blake & Mitchell, Spartan Books, 1972 and "Detection of Ball Bearing Malfunction," *Inst. & Control*, Dec. 1970.

CONCLUSION

In conclusion, it has been found that the RMS converter is a versatile component. Applications range from complex current waveform measurement to ball bearing failure monitor. The examples cited in this note are but a few of the many possible applications.

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3-Terminal Regulator is Adjustable



INTRODUCTION

Until now, all of the 3-terminal power IC voltage regulators have a fixed output voltage. In spite of this limitation, their ease of use, low cost, and full on-chip overload protection have generated wide acceptance. Now, with the introduction of the LM117, it is possible to use a single regulator for any output voltage from 1.2V to 37V at 1.5A. Selecting close-tolerance output voltage parts or designing discrete regulators for particular applications is no longer necessary since the output voltage can be adjusted. Further, only one regulator type need be stocked for a wide range of applications. Additionally, an adjustable regulator is more versatile, lending itself to many applications not suitable for fixed output devices.

In addition to adjustability, the new regulator features performance a factor of 10 better than fixed output regulators. Line regulation is 0.01%/V and load regulation is only 0.1%. It is packaged in standard TO-3 transistor packages so that heat sinking is easily accomplished with standard heat sinks. Besides higher performance, overload protection circuitry is improved, increasing reliability.

ADJUSTABLE REGULATOR CIRCUIT

The adjustment of a 3-terminal regulator can be easily understood by referring to *Figure 1*, which shows a functional circuit. An op amp, connected as a unity gain buffer, drives a power Darlington. The op amp and biasing circuitry for the regulator are arranged so that all the quiescent current is delivered to the regulator output (rather than ground) eliminating the need for a separate ground terminal. Further, all the circuitry is designed to operate over the 2V to 40V input to output differential of the regulator.

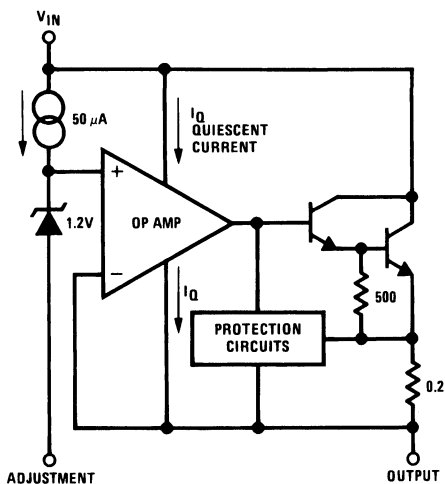


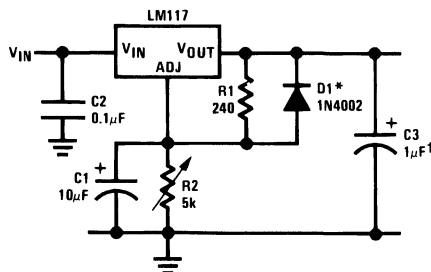
FIGURE 1. Functional Schematic of the LM117

A 1.2V reference voltage appears inserted between the non-inverting input of the op amp and the adjustment terminal. About 50 μA is needed to bias the reference and this current comes out of the adjustment terminal. In operation, the output of the regulator is the voltage of the adjustment terminal plus 1.2V. If the adjustment terminal is grounded, the device acts as a 1.2V regulator. For higher output voltages, a divider R1 and R2 is connected from the output to ground as is shown in *Figure 2*. The 1.2V reference across resistor R1 forces 5 mA of current to flow. This 5 mA then flows through R2, increasing the voltage at the adjustment terminal and therefore the output voltage. The output voltage is given by:

$$V_{OUT} = 1.2V \left(1 + \frac{R2}{R1} \right) + 50 \mu A R2$$

The 50 μA biasing current is small compared to 5 mA and causes only a small error in actual output voltages. Further, it is extremely well regulated against line voltage or load current changes so that it contributes virtually no error to dynamic regulation. Of course, programming currents other than 5 mA can be used depending upon the application.

Since the regulator is floating, all the quiescent current must be absorbed by the load. With too light of a load, regulation is impaired. Usually the 5 mA programming current is sufficient; however, worst case minimum load for commercial grade parts requires a minimum load of 10 mA. The minimum load current can be compared to the quiescent current of standard regulators.



† Solid tantalum

*Discharges C1 if output is shorted to ground

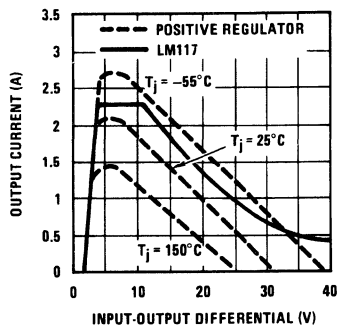
TL/H/1532-2

FIGURE 2. Adjustable Regulator with Improved Ripple Rejection

OVERLOAD PROTECTION CIRCUITRY

An important advancement in the LM117 is improved current limit circuitry. Current limit is set internally at about 2.2A and the current limit remains constant with temperature. Older devices such as the LM309 or LM7800 regulators use the turn-on of an emitter-base junction of a transistor to set the current limit. This causes current limit to typically change by a factor of 2 over a -55°C to $+150^{\circ}\text{C}$ temperature range. Further, to insure adequate output current at 150°C the current limit is relatively high at 25°C , which can cause problems by overloading the input supply.

Also included is safe-area protection for the pass transistor to decrease the current limit as input-to-output voltage differential increases. The safe area protection circuit in the LM117 allows full output current at 15V differential and does not allow the current limit to drop to zero at high input-to-output differential voltages, thus preventing start up problems with high input voltages. Figure 3 compares the current limit of the LM117 to an LM340 regulator.



TL/H/1532-3

FIGURE 3. Comparison of LM117 Current Limit with Older Positive Regulator

Thermal overload protection, included on the chip, turns the regulator OFF when the chip temperature exceeds about 170°C , preventing destruction due to excessive heating. Previously, the thermal limit circuitry required about 7V to operate. The LM117 has a new design that is operative down to about 2V. Further, the thermal limit and current limit circuitry in the LM117 are functional, even if the adjustment terminal should be accidentally disconnected.

OPERATING THE LM117

The basic regulator connection for the LM117, as shown in Figure 2, only requires the addition of 2 resistors and a standard input bypass capacitor. Resistor R2 sets the output voltage while R1 provides the 5 mA programming current. The 2 capacitors on the adjustment and output terminals are optional for improved performance.

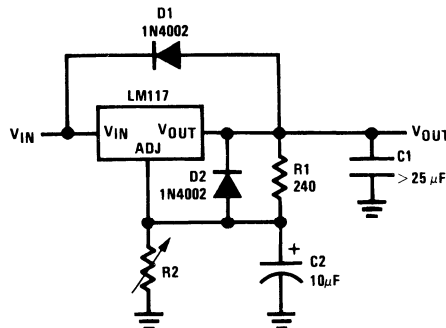
Bypassing the adjustment terminal to ground improves ripple rejection. This bypass capacitor prevents ripple from being amplified as the output voltage is increased. With a $10\ \mu\text{F}$ bypass capacitor, 80 dB ripple rejection is obtainable at any output level. Increases over $10\ \mu\text{F}$ do not appreciably improve the ripple rejection at 120 Hz. If a bypass capacitor is used, it is sometimes necessary to include protection

diodes as discussed later, to prevent the capacitor from discharging through internal low current paths in the LM117 and damaging the device.

Although the LM117 is stable with no output capacitors, like any feedback circuit, certain values of external capacitance can cause excessive ringing. This occurs with values between 500 pF and 5000 pF. A $1\ \mu\text{F}$ solid tantalum (or $25\ \mu\text{F}$ aluminum electrolytic) on the output swamps this effect and insures stability. When external capacitors are used with any IC regulator, it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator. Most $10\ \mu\text{F}$ capacitors have low enough internal series resistance to deliver 20A spikes when shorted. Although the surge is short, there is enough energy to damage parts of the IC.

When an output capacitor is connected to a regulator and the input is shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage of the regulator, and the rate of decrease of V_{IN} . In the LM117, this discharge path is through a large junction that is able to sustain a 20A surge with no problem. This is not true of other types of positive regulators. For output capacitors of $25\ \mu\text{F}$ or less, there is no need to use diodes.

The bypass capacitor on the adjustment terminal (C2) can discharge through a low current junction. Discharge occurs when either the input or output is shorted. Internal to the LM117 is a $50\ \Omega$ resistor which limits the peak discharge current. No protection is needed for output voltages of 25V and less than $10\ \mu\text{F}$ capacitance. Figure 4 shows an LM117 with protection diodes included for use with outputs greater than 25V and high values of output capacitance.



TL/H/1532-4

$$V_{OUT} = 1.25V \left(1 + \frac{R2}{R1} \right) + R2 \cdot I_{ADJ}$$

D1 protects against C1 (input shorts)

D2 protects against C2 (output shorts)

FIGURE 4. Regulator with Protection Diodes Against Capacitor Discharge

Some care should be taken in making connection to the LM117 to achieve the best load regulation. Series resistance between the output of the regulator and programming resistor R1 should be minimized. Any voltage drop due to load current through this series resistance appears as a change in the reference voltage and degrades regulation. If possible, 2 wires should be connected to the output—1 for load current and 1 for resistor R1. The ground of R2 can

be returned near the ground of the load to provide remote sensing and improve load regulation.

APPLICATIONS

Figure 5 shows a 0V to 25V general purpose lab supply. Operation of the LM317 down to 0V output requires the addition of a negative supply so that the adjustment terminal can be driven to -1.2V. An LM329 6.9V reference is used to provide a regulated -1.2V reference to the bottom of adjustment pot R2. The LM329 is an IC zener which has exceptionally low dynamic impedance so the negative supply need not be well regulated. Note that a 10 mA programming current is used since lab supplies are often used with no-load, and the LM317 requires a worst-case minimum load of 10 mA.

The 1.2V minimum output of the LM117 makes it easy to design power supplies with electrical shut-down. At 1.2V, most circuits draw only a small fraction of their normal operating current. In Figure 6 a TTL input signal causes Q1 to ground the adjustment terminal decreasing the output to 1.2V. If true zero output is desired, the adjustment can be driven to -1.2V; however, this does require a separate negative supply.

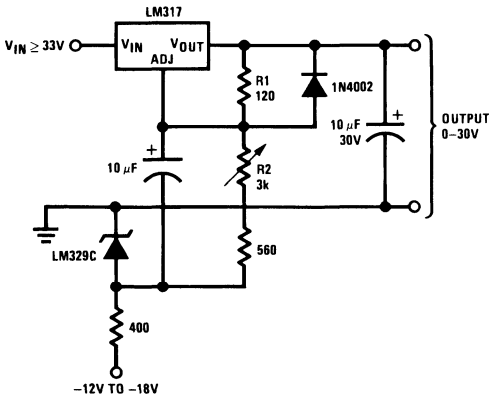
When fixed output voltage regulators are used as on-card regulator for multiple cards, the normal output voltage tolerance of ±5% between regulators can cause as much as 10% difference in operating voltage between cards.

This can cause operating speed differences in digital circuitry, interfacing problems or decrease noise margins.

Figure 7 shows a method of adjusting multiple on-card regulators so that all outputs track within ±100 mV. The adjustment terminals of all devices are tied together and a single divider is used to set the outputs. Programming current is set at 10 mA to minimize the effects of the 50 μA biasing current of the regulators and should further be increased if many LM117's are used. Diodes connected across each regulator insure that all outputs will decrease if 1 regulator is shorted.

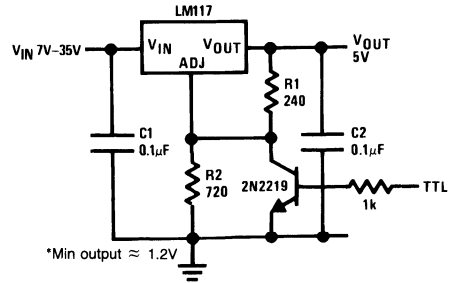
Two terminal current regulators can be made with fixed-output regulators; however, their high output voltage and high quiescent current limit their accuracy. With the LM117 as shown in Figure 8, a high performance current source useful from 10 mA to 1.5A can be made. Current regulation is typically 0.01%/V even at low currents since the quiescent current does not cause an error. Minimum operating voltage is less than 4V, so it is also useful as an in-line adjustable current limiter for protection of other circuitry.

Low cost adjustable switching regulators can be made using an LM317 as the control element. Figure 9 shows the simplest configuration. A power PNP is used as the switch driving an L-C filter. Positive feedback for hysteresis is applied to the LM317 through R6. When the PNP switches, a small square wave is generated across R5. This is level shifted and applied to the adjustment terminal of the regulator by R4 and C2, causing it to switch ON or OFF. Negative



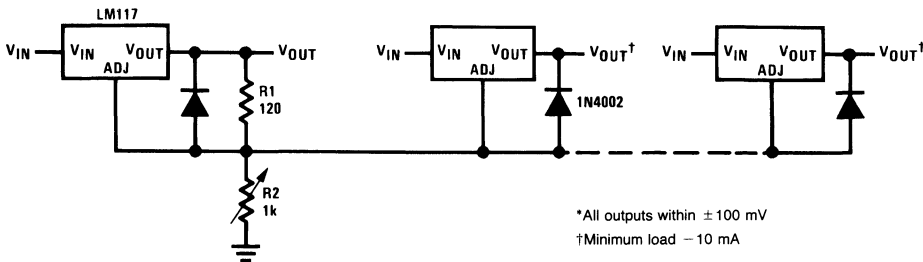
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FIGURE 5. General Purpose 0-30V Power Supply



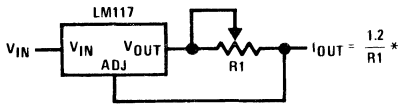
TL/H/1532-6

FIGURE 6. 5V Logic Regulator with Electronic Shutdown*



TL/H/1532-7

FIGURE 7. Adjusting Multiple On-Card Regulators with Single Control*



$^*0.8\Omega \leq R1 \leq 120\Omega$

TL/H/1532-8

FIGURE 8. Precision Current Limiter

feedback is taken from the output through R3, making the circuit oscillate. Capacitor C3 acts as a speed-up, increasing switching speed, while R2 limits the peak drive current to Q1.

The circuit in *Figure 9* provides no protection for Q1 in case of an overload. A blow-out proof switching regulator is shown in *Figure 10*. The PNP transistor has been replaced by a PNP-NPN combination with LM395's used as the NPN transistors. The LM395 is an IC which acts as an NPN transistor with overload protection. Included on the LM395 is current limiting, safe-area protection and thermal overload protection making the device virtually immune to any type of overload.

Efficiency for the regulators ranges from 65% to 85%, depending on output voltage. At low output voltages, fixed power losses are a greater percentage of the total output power so efficiency is lowest. Operating frequency is about 30 kHz and ripple is about 150 mV, depending upon input voltage. Load regulation is about 50 mV and line regulation about 1% for a 10V input change.

One of the more unique applications for these switching regulators is as a tracking pre-regulator. The only DC connection to ground on either regulator is through the 100Ω resistor (R5 or R8) that sets the hysteresis. Instead of tying this resistor to ground, it can be connected to the output of

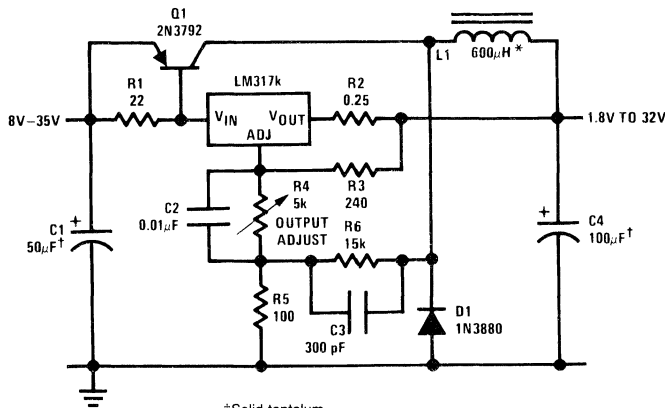
a linear regulator so that the switching regulator maintains a constant input-to-output differential on the linear regulator. The switching regulator would typically be set to hold the input voltage to the linear regulator about 3V higher than the output.

Battery charging is another application uniquely suited for the LM117. Since battery voltage is dependent on electrochemical reactions, the charger must be designed specifically for the battery type and number of cells. Ni-Cads are easily charged with the constant current sources shown previously. For float chargers on lead-acid type batteries all that is necessary is to set the output of the LM117 at the float voltage and connect it to the battery. An adjustable regulator is mandatory since, for long battery life the float voltage must be precisely controlled. The output voltage temperature coefficient can be matched to the battery by inserting diodes in series with the adjustment resistor for the regulator and coupling the diodes to the battery.

A high performance charger for gelled electrolyte lead-acid batteries is shown in *Figure 11*. This charger is designed to quickly recharge a battery and shut off at full charge.

Initially, the charging current is limited to 2A by the internal current limit of the LM117. As the battery voltage rises, current to the battery decreases and when the current has decreased to 150 mA, the charger switches to a lower float voltage preventing overcharge. With a discharged battery, the start switch is not needed since the charger will start by itself; however, it is included to allow topping off even slightly discharged batteries.

When the start switch is pushed, the output of the charger goes to 14.5V set by R1, R2 and R3. Output current is sensed across R6 and compared to a fraction of the 1.2V

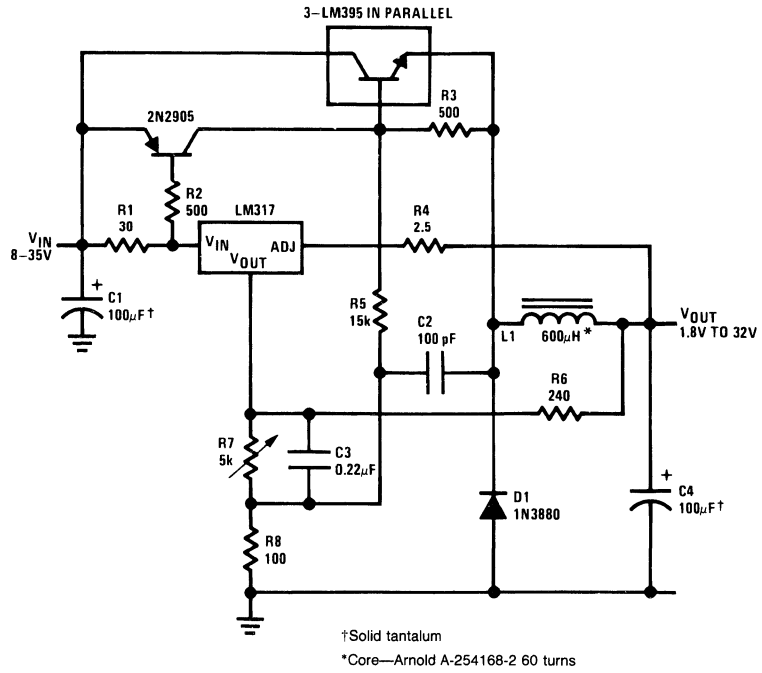


†Solid tantalum

*Core—Arnold A-254168-2 60 turns

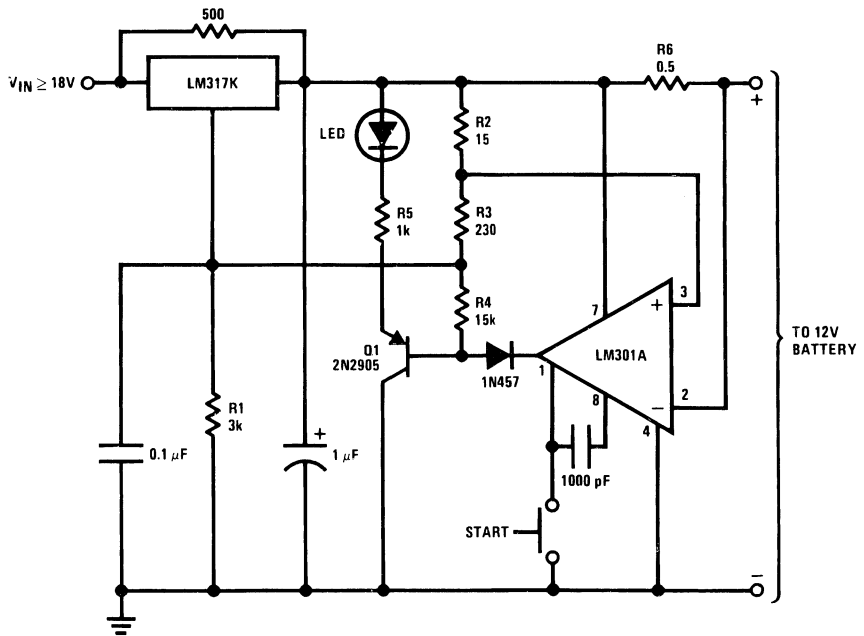
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FIGURE 9. Low Cost 3A Switching Regulator



TL/H/1532-10

FIGURE 10. 4A Switching Regulator with Overload Protection



TL/H/1532-11

FIGURE 11. 12V Battery Charger

reference (across R2) by an LM301A op amp. As the voltage across R6 decreases below the voltage across R2, the output of the LM101A goes low shunting R1 with R4. This decreases the output voltage from 14.5V to about 12.5V terminating the charging. Transistor Q1 then lights the LED as a visual indication of full charge.

The LM117 can even be used as a peak clipping AC voltage regulator. Two regulators are used, 1 for each polarity of the input as shown in *Figure 12*. Internal to the LM117 is a diode from input-to-output which conducts the current around the device when the opposite regulator is active. Since each regulator is operating independently, the positive and negative peaks must be set separately for a symmetrical output.

CONCLUSIONS

A new IC power voltage regulator has been developed which is significantly more versatile than older devices. The output voltage is adjustable, in addition to improved regulation specifications. Further, reliability is increased in 2 fashions. Overload protection circuitry has been improved to make the device less susceptible to fault conditions and under short circuit conditions, minimum stress is transmitted back to the input power supply. Secondly, the device is 100% burned-in under short circuit conditions at the time of manufacture. Finally, the LM117 is made with a standard IC production process and packaged in a standard TO-3 power package, keeping costs low.

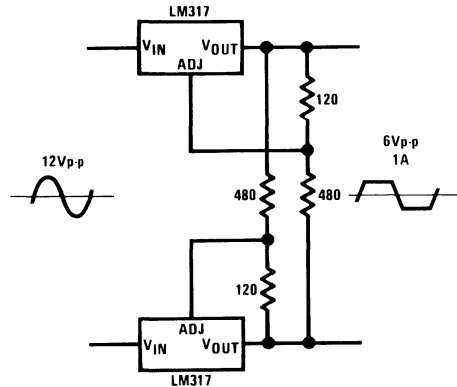


FIGURE 12. AC Voltage Regulator

TL/H/1532-12

Improving Power Supply Reliability with IC Power Regulators

National Semiconductor
Application Note 182



Three-terminal IC power regulators include on-chip overload protection against virtually any normal fault condition. Current limiting protects against short circuits fusing the aluminum interconnects on the chip. Safe-area protection decreases the available output current at high input voltages to insure that the internal power transistor operates within its safe area. Finally, thermal overload protection turns off the regulator at chip temperatures of about 170°C, preventing destruction due to excessive heating. Even though the IC is fully protected against normal overloads, careful design must be used to insure reliable operation in the system.

SHORT CIRCUITS CAN OVERLOAD THE INPUT

The IC is protected against short circuits, but the value of the on-chip current limit can overload the input rectifiers or transformer. The on-chip current limit is usually set by the manufacturer so that with worst-case production variations and operating temperature the device will still provide rated output current. Older types of regulators, such as the LM309, LM340 or LM7800 can have current limits of 3 times their rated output current.

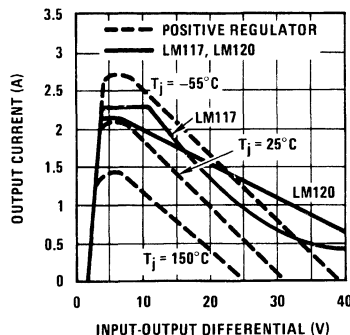
The current limit circuitry in these devices uses the turn-on voltage of an emitter-base junction of a transistor to set the current limit. The temperature coefficient of this junction combined with the temperature coefficient of the internal resistors gives the current limit a $-0.5\%/^{\circ}\text{C}$ temperature coefficient. Since devices must operate and provide rated current at 150°C, the 25°C current limit is 120% higher than typical. Production variations will add another $\pm 20\%$ to initial current limit tolerance so a typical 1A part may have a 3A current limit at 25°C. This magnitude of overload current can blow the input transformer or rectifiers if not considered in the initial design—even though it does not damage the IC. One way around this problem (other than fuses) is by the use of minimum size heat sinks. The heat sink is designed for only normal operation. Under overload conditions, the device (and heat sink) are allowed to heat up to the thermal shut-down temperature. When the device shuts down, loading on the input is reduced.

Newer regulators have improved current limiting circuitry. Devices like the LM117 adjustable regulator, LM123, 3A, 5V logic regulator or the LM120 negative regulators have a relatively temperature-stable current limit. Typically these devices hold the current limit within $\pm 10\%$ over the full -55°C to $+150^{\circ}\text{C}$ operating range. A device rated for 1.5A output will typically have a 2.2A current limit, greatly easing the problem of input overloads.

Many of the older IC regulators can oscillate when in current limit. This does not hurt the regulator and is mostly dependent upon input bypassing capacitors. Since there is a large variability between regulator types and manufacturers, there is no single solution to eliminating oscillations. Generally, if oscillations cause other circuit problems, either a solid tantalum input capacitor or a solid tantalum in series with 5Ω to 10Ω will cure the problem. If one doesn't work, try the other. Start-up problems can occur from the current limit circuitry too. At high input-output differentials, the current limit is decreased by the safe-area protection. In most regulators the

decrease is linear, and at input-output voltages of about 30V the output current can decrease to zero. Normally this causes no problem since, when the regulator is initially powered, the output increases as the input increases. If such a regulator is running with, for example, 30V input and 15V output and the output is momentarily shorted, the input-output differential increases to 30V and available output current is zero. Then the output of the regulator stays at zero even if the short is removed. Of course, if the input is turned OFF, then ON, the regulator will come up to operating voltage again. The LM117 is the only regulator which is designed with a new safe-area protection circuit so output current does not decrease to zero, even at 40V differential.

This type of start-up problem is particularly load dependent. Loads to a separate negative supply or constant-current devices are among the worst. Another, usually overlooked, load is pilot lights. Incandescent bulbs draw 8 times as much current when cold as when operating. This severely adds to the load on a regulator, and may prevent turn-on. About the only solutions are to use an LM117 type device, or bypass the regulator with a resistor from input to output to supply some start-up current to the load. Resistor bypassing will not degrade regulation if, under worst-case conditions of maximum input voltage and minimum load current, the regulator is still delivering output current rather than absorbing current from the resistor. *Figure 1* shows the output current of several different regulators as a function of output voltage and temperature.



TL/H/7458-1

FIGURE 1. Comparison of LM117 Current Limit with Older Positive Regulator

When a positive regulator (except for the LM117) is loaded to a negative supply, the problem of start-up can be doubly bad. First, there is the problem of the safe-area protection as mentioned earlier. Secondly, the internal circuitry cannot supply much output current when the output pin is driven more negative than the ground pin of the regulator. Even with low input voltages, some positive regulators will not start when loaded by 50 mA to a negative supply. Clamping the output to ground with a germanium or Schottky diode usually solves this problem. Negative regulators, because of different internal circuitry, do not suffer from this problem.

DIODES PROTECT AGAINST CAPACITOR DISCHARGE

It is well recognized that improper connections to a 3-terminal regulator will cause its destruction. Wrong polarity inputs or driving current into the output (such as a short between a 5V and 15V supply) can force high currents through small area junctions in the IC, destroying them. However, improper polarities can be applied accidentally under many normal operating conditions, and the transient condition is often gone before it is recognized.

Perhaps the most likely sources of transients are external capacitors used with regulators. Figure 2 shows the discharge path for different capacitors used with a positive regulator. Input capacitance, C1, will not cause a problem under any conditions. Capacitance on the ground pin (or adjustment pin is the case of the LM117) can discharge through 2 paths which have low current junctions.

If the output is shorted, C2 will discharge through the ground pin, possibly damaging the regulator. A reverse-biased diode, D2, diverts the current around the regulator, protecting it. If the input is shorted, C3 can discharge through the output pin, again damaging the regulator. Diode D1 protects against C3, preventing damage. Also, with both D1 and D2 in the circuit, when the input is shorted, C2 is discharged through both diodes, rather than the ground pin.

In general, these protective diodes are a good idea on all positive regulators. At higher output voltages, they become more important since the energy stored in the capacitors is larger. With negative regulators and the LM117, there is an internal diode in parallel with D1 from output-to-input, eliminating the need for an external diode if the output capacitor is less than 25 μ F.

Another transient condition which has been shown to cause problems is momentary loss of the ground connection. This charges the output capacitor to the unregulated input voltage minus a 1—2V drop across the regulator. If the ground is then connected, the output capacitor, C3, discharges through the regulator output to the ground pin, destroying it. In most cases, this problem occurs when a regulator (or card) is plugged into a powered system and the input pin is

connected before the ground. Control of the connector configuration, such as using 2 ground pins to insure ground is connected first, is the best way of preventing this problem. Electrical protection is cumbersome. About the only way to protect the regulator electrically is to make D2 a power zener 1V to 2V above the regulator voltage and include 10 Ω to 50 Ω in the ground lead to limit the current.

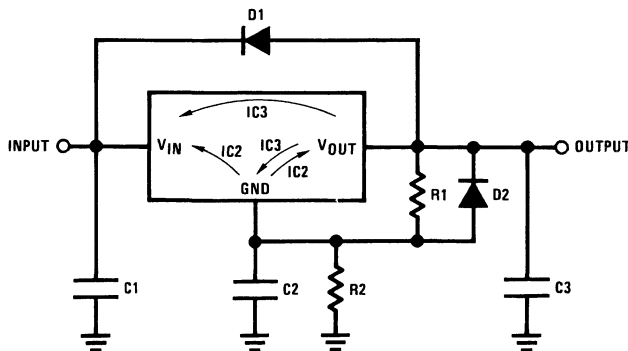
LOW OPERATING TEMPERATURE INCREASES LIFE

Like any semiconductor circuit, lower operating temperature improves reliability. Operating life decreases at high junction temperatures. Although many regulators are rated to meet specifications at 150°C, it is not a good idea to design for continuous operation at that temperature. A reasonable maximum operating temperature would be 100°C for epoxy packaged devices and 125°C for hermetically sealed (TO-3) devices. Of course, the lower the better, and decreasing the above temperatures by 25°C for normal operation is still reasonable.

Another benefit of lowered operating temperatures is improved power cycle life for low cost soft soldered packages. Many of today's power devices (transistors included) are assembled using a TO-220 or TO-3 aluminum soft solder system. With temperature excursions, the solder work-hardens and with enough cycles the solder will ultimately fail. The larger the temperature change, the sooner failure will occur. Failures can start at about 5000 cycles with a 100°C temperature excursion. This necessitates, for example, either a large heat sink or a regulator assembled with a hard solder, such as steel packages, for equipment that is continuously cycled ON and OFF.

THERMAL LIMITING GIVES ABSOLUTE PROTECTION

Without thermal overload protection, the other protection circuitry will only protect against short term overloads. With thermal limiting, a regulator is not destroyed by long time short circuits, overloads at high temperatures or inadequate heat sinking. In fact, this overload protection makes the IC regulator tolerant of virtually any abuse, with the possible exception of high-voltage transients, which are usually filtered by the capacitors in most power supplies.



TL/H/7458-2

FIGURE 2. Positive Regulator with Diode Protection Against Transient Capacitor Discharge

One problem with thermal limiting is testing. With a 3-terminal regulator, short-circuit protection and safe-area protection are easily measured electrically. For thermal limiting to operate properly, the electrical circuitry on the IC must function and the IC chip must be well die-attached to the package so there are no hot spots. About the only way to insure that thermal limiting works is to power the regulator, short the output, and let it cook. If the regulator still works after 5 minutes (or more) the thermal limit has protected the regulator.

This type of testing is time consuming and expensive for the manufacturer so it is not always done. Some regulators, such as the LM117, LM137, LM120 and LM123, do receive an electrical burn-in in thermal shutdown as part of their testing. This insures that the thermal limiting works as well as reducing infant mortality. If it is probable that a power supply will have overloads which cause the IC to thermally limit, testing the regulator is in order.

References for A/D Converters

National Semiconductor
Application Note 184



Interfacing between digital and analog signals is becoming increasingly important with the proliferation of digital signal processing. System accuracy is often limited by the accuracy of the converter and a limitation of the converter is the voltage reference. Design can be difficult if the reference is external.

The accuracy of any converter is limited by the temperature drift or long term drift of the voltage reference, even if conversion linearity is perfect. Assuming that the voltage reference is allowed to add 1/2 least significant bit error (LSB) to the converter, it is surprising how good the reference must be when even small temperature excursions are considered. When temperature changes are large, the reference design is a major problem. Table I shows the reference requirements for different converters while Table II shows how the same problems exist with digital panel meters.

The voltage reference circuitry is required to do several functions to maintain a stable output. First, input power supply changes must be rejected by the reference circuitry. Secondly, the zener used in the reference must be biased properly, while other parts of circuitry scale the typical zener voltage and provides a low impedance output. Finally, the reference circuitry must reject ambient temperature changes so that the temperature drift of the reference circuitry plus the drift of the zener does not exceed the desired drift limit.

While zener temperature coefficient is obviously critical to reference performance, other sources of drift can easily add as much error as zener — even in voltage references with modest performance of 20 ppm/°C temperature drift. Zener drift and op amp drift add directly to the drift error, while resistor error is only a function of how well the scaling resistors track. Resistors which have a high TC can be used if they track.

For a 10V output with a 6.9V zener, the drift contribution of resistor mistracking is about 0.4 since the gain is 1.4. The range of temperature coefficient errors for different components used to make a 10V reference from a 6.9V zener are shown in Table III. Another potential source of error, input supply variations, are negligible if the input is 1% regulated, and the resistor feeding the zener is stable to 1%.

Less frequently specified sources of error in voltage reference zeners are hysteresis and stress sensitivity. Stress on either a zener-diode junction or the series-temperature-compensating junction will cause voltage shifts. The axial leads on discrete devices can transmit stress from outside the package to the junction, causing 1 mV to 5 mV shifts.

Temperature cycling is the discrete zener can also induce non-reversible changes in zener voltage. If a zener is heated from 25°C to 100°C and then back to 25°C, the zener voltage may not return to its original value. This is because the temperature cycle has permanently changed the stress in the die, changing the voltage. This effect can be as high as 5 mV in some diodes and may be cumulative with many temperature cycles. The new planar IC zeners, such as the LM199 (temperature stabilized) or the LM129 are insensitive to stress and show only about 50 μV of hysteresis for a 150°C temperature cycle since the package does not stress the silicon chip.

DESIGNING THE REFERENCE

If moderate temperature performance such as 20 ppm/°C is all that is needed, 2 different approaches can be used in the reference design. In the first, the temperature drift error is split equally between the zener and the amplifier or scaling resistors. This requires a moderately low drift zener and op amp with 10 ppm resistors.

TABLE I. Maximum Allowable Reference Drift for 1/2 Least Significant Bits Error of Binary Coded Converter

TEMP CHANGE	BITS					
	6	8	10	12	14	
25°C	310	80	20	5	1.25	ppm/°C
50°C	160	40	10	2.5	0.6	ppm/°C
100°C	80	20	5	1.2	0.3	ppm/°C
125°C	63	16	3	1	0.2	ppm/°C

TABLE II. Maximum Allowable Reference Drift for 1/2 Digit Error of Digital Meters

TEMP CHANGE	DIGITS								
	2	2½	3	3½	4	4½	5	5½	
25°C	200	100	20	10	2	1	0.2	0.1	ppm/°C
5°C			100	50	10	5	1	0.5	ppm/°C

*0.01%/°C = 100 ppm/°C, 0.001%/°C = 10 ppm/°C, 0.0001%/°C = 1 ppm/°C

TABLE III. Drift Error Contribution From Reference Components for a 10V Reference

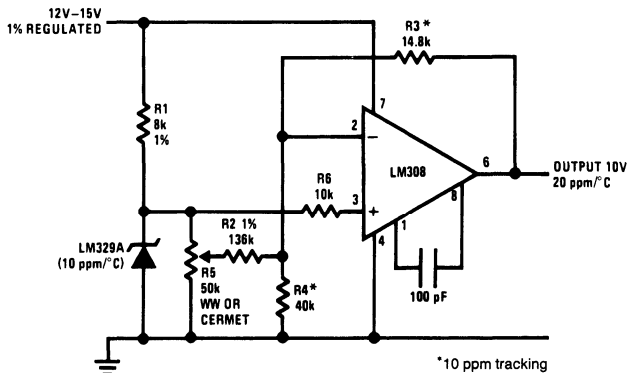
DEVICE	ERROR	10V OUTPUT DRIFT
Zener		
Zener Drift		
LM199A	0.5 ppm/°C	0.5 ppm/°C
LM199, LM399A	1 ppm/°C	1 ppm/°C
LM399	2 ppm/°C	2 ppm/°C
1N829, LM3999	5 ppm/°C	5 ppm/°C
LM129, 1N823A, 1N827A, LM329A	10–50 ppm/°C	10–50 ppm/°C
LM329, 1N821, 1N825	20–100 ppm/°C	20–100 ppm/°C
Op Amp		
Offset Voltage Drift		
LM725, LH0044, LM121	1 $\mu\text{V}/^\circ\text{C}$	0.15 ppm/°C
LM108A, LM208A, LM308A	5 $\mu\text{V}/^\circ\text{C}$	0.7 ppm/°C
LM741, LM101A	15 $\mu\text{V}/^\circ\text{C}$	2 ppm/°C
LM741C, LM301A, LM308	30 $\mu\text{V}/^\circ\text{C}$	4 ppm/°C
Resistors		
Resistance Ratio Drift		
1% (RN55D)	50–100 ppm	20–40 ppm/°C
0.1% (Wirewound)	5–10	2–4 ppm
Tracking 1 ppm Film or Wirewound	—	0.4 ppm/°C

The second approach uses a very low drift zener and allows the buffer amplifier or scaling resistor to cause most of the drift error. This type of design is now made economical by the availability of low cost temperature stabilized IC zeners with virtually no TC. Further, the temperature coefficient of this reference is easily upgraded, if necessary. The 2 reference circuits are shown in *Figure 1a* and *Figure 1b*.

In *Figure 1a*, an LM308 op amp is used to increase the typical zener output to 10V while adding a worst-case drift of 4 ppm/°C to the 10 ppm/°C of the zener. Resistors R3 and R4 should track to better than 10 ppm bringing the total error so far to 18 ppm. Since the output must be adjusted to eliminate the initial zener tolerance, a pot, R5 and R2 have been added. The loading on the pot by R2 is small, and there is no tracking requirement between the pot and R2. It is necessary for R2 to track R3 and R4 within 50 ppm.

In *Figure 1b*, a low drift reference and op amp are used to give a total drift, exclusive of resistors of 3 ppm/°C. Now the resistor tracking requirement is relaxed to about 50 ppm, allowing ordinary 1% resistors to be used. The circuit in *Figure 1b* is modified easily for applications requiring 3 ppm/°C to 5 ppm/°C overall drift by tightening the tracking of the resistors. For more accurate applications, the Kelvin sensing for both output and ground should be used. For even lower drifts, substituting a 1 $\mu\text{V}/^\circ\text{C}$ op amp, 1 ppm tracking resistors and an LM199A zener, overall drifts of 1 ppm/°C can be achieved. In both of the circuits, it is important to remember that the tracking of resistors can, at worst-case, be twice temperature drift of either resistance.

In both circuits, the zener is biased by a single resistor from the supply, rather than from the reference output. This eliminates possible start-up problems and, because of the 1 Ω dynamic impedance of the IC zeners, only



TL/H/5615-1

FIGURE 1a. 10V, 20 ppm Reference Using a Low Cost Zener and Low Drift Resistors

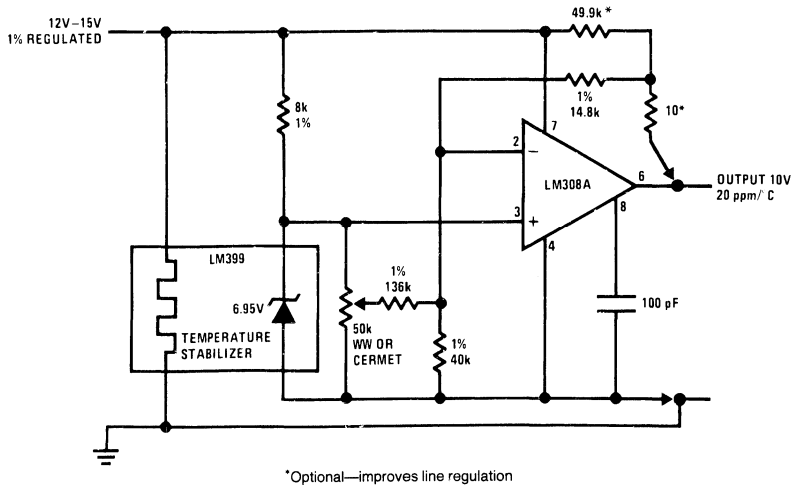


FIGURE 1b. 10V Reference has Low Drift Reference and Standard 1% Resistors. Kelvin Sensing is Shown with Compensation for Line Changes.

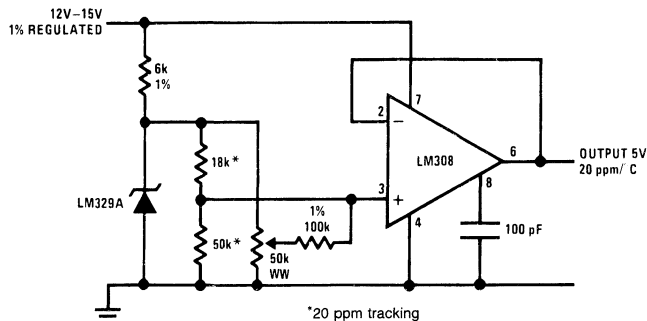


FIGURE 2. Low Voltage Reference

TL/H/5615-2

adds about $20 \mu\text{V}$ of error. Compensation for input changes is shown in *Figure 1b*. Conventional zeners do not allow this biasing. A conventional 5 ppm reference such as the 1N829 has a dynamic impedance of about 15Ω . If it is biased from a resistor from a 1% regulated 15V supply, the operating current can change by 1.7% or $127 \mu\text{A}$. This will shift the zener voltage by 1.9 mV or 60 ppm . With the IC zeners operating at 1 mA , a 1% shift in the supply will change the reference by $20 \mu\text{V}$ or 3 ppm . Further, power dissipation in the IC is only 7 mW , giving low warm-up drift compared to 7.5 mA zeners. The biasing resistor for the IC zener need not be any better than an ordinary 1% resistor since performance is independent of current.

When output voltages less than the zener voltage are desired, the IC zeners significantly simplify circuit design since no auxiliary regulator is needed for biasing. *Figure 2* shows a 5V reference circuit for use with a 15V input. In this case,

zener drift contributes proportionally to the output drift while op amp offset drift adds a greater rate. With the 10V reference, $15 \mu\text{V}/^\circ\text{C}$ from the op amp contributed $2 \text{ ppm}/^\circ\text{C}$ drift, but for the 5V reference, $15 \mu\text{V}/^\circ\text{C}$ adds $3 \text{ ppm}/^\circ\text{C}$. This makes op amp choice more important as the output voltage is lowered. Of course, if a high output impedance is tolerable, the op amp can be eliminated.

APPROACHING THE ULTIMATE DRIFT

To obtain the lowest possible drifts, temperature coefficient trimming is necessary. With discrete zeners, the operating current can sometimes be trimmed to change the TC of the reference; however, the temperature coefficient is not always linear or predictable. With the new IC zeners, TC is independent of operating current so trimming must be done elsewhere in the circuit. The lowest drift components should be used since

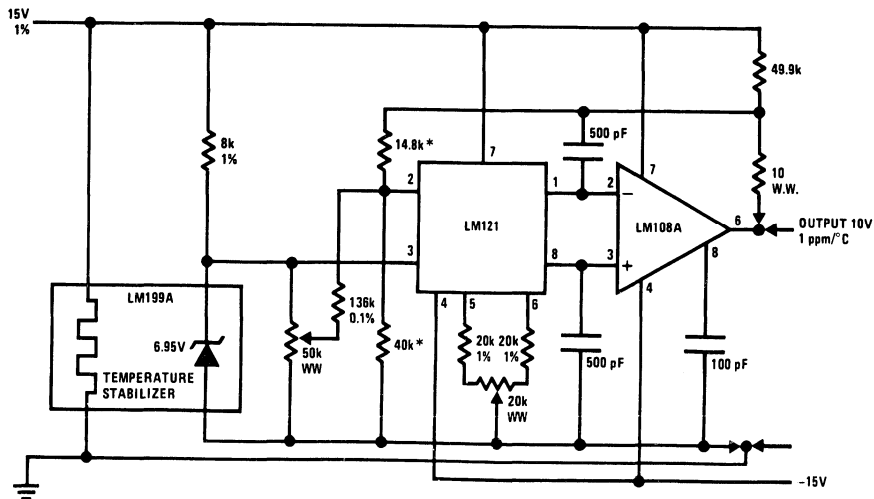


FIGURE 3. Ultra Low Drift Reference

*1 ppm tracking TL/H/5615-3

trimming can only remove a linear component of drift. High TC devices can have a highly non-linear drift, making trimming difficult.

Figure 3 shows a circuit suitable for trimming. An LM199A reference with 0.5 ppm/°C drift is used with a 121/108 op amp. Resistors should be 1 ppm tracking to give overall untrimmed drifts of about 0.9 ppm. The 121/108 is a low drift amplifier combination where drift is predictably proportional to offset voltage. An offset can be set for the 108/121 combination to cancel the measured drift with 1 pass calibration.

Trimming procedure is as follows: the zener is disconnected and the input of the op amp grounded. Then the offset of the op amp is nulled out to zero. Reconnecting the zener, the output is adjusted to precisely 10V. A temperature run is made and the drift noted. The op amp will drift 3.6 $\mu\text{V}/^\circ\text{C}$ for every 1 mV of offset, so for every 5 $\mu\text{V}/^\circ\text{C}$ drift at the output, the offset of the op amp is adjusted 1 mV (1.4 mV measured at the output) in the opposite direction. The output is readjusted to 10V and the drift checked.

Although this trimming scheme was chosen since only a single adjustment is usually required, compensation is not always perfect. Hysteresis effects can appear in resistors or op amps as well as zeners. Best results can be obtained by cycling the circuit to temperature a few times before taking data to relieve assembly stresses on the components. Also, oven testing can sometimes cause thermal gradients across circuits, giving 50 μV to 100 μV of error. However, with careful layout and trimming, overall reference drifts of 0.1 ppm/°C to 0.2 ppm/°C can be achieved.

There are 2 other possible problem areas to be considered before final layout. Good single point grounding is important. Traces on a PC board can easily have 0.1 Ω and only 10 mA will cause a 1 mV shift. Also, since these references are close to high-speed digital circuitry, shielding may be necessary to prevent pick-up at the inputs of the op amp. Transient response to pick-up or rapid loading changes can sometimes be improved by a large capacitor. (1 μF —10 μF) directly on the op amp output; but this will depend on the stability of the op amp.

Single Chip Data Acquisition System Simplifies Analog-to-Digital Conversion

National Semiconductor
Application Note 193



Until recently, building an analog data acquisition system required a hardy cross-breed of both analog design and digital design. Now National Semiconductor has simplified the design problem of a data acquisition system with the introduction of the ADC0816 (MM74C948). This CMOS device incorporates many of the standard features of a data acquisition system onto a single chip. Included on-chip is an 8-bit analog-to-digital converter with bus oriented outputs, a 16-channel expandable multiplexer, provisions for external signal conditioning, and logic control for systems interface. This chip marks the advent of a new generation in A/D converters, bringing versatility, performance, and economy using a technology ideally suited to data acquisition systems.

Figure 1 shows a block diagram of the functions provided within a single package. The chip duplicates the classical

structure of a data acquisition system while relieving the user from multichip interface and compatibility problems. A wide range of functional options allows extremely versatile operation of the device in a wide range of applications.

The ADC0816 uses National's low voltage, metal gate technology. The device operates from a single +5V supply and features a 16-channel multiplexer with address input latches, latched TRI-STATE® outputs and a true eight-bit-accurate analog-to-digital converter. It consumes only 20 mW of power. Total conversion time of an analog signal is 100 μ s. By using a patented A/D conversion technique the converter is guaranteed to have no missing codes and to be monotonic. The internal chopper stabilized comparator is the key element in minimizing both long term drift and temperature coefficients of other error terms.

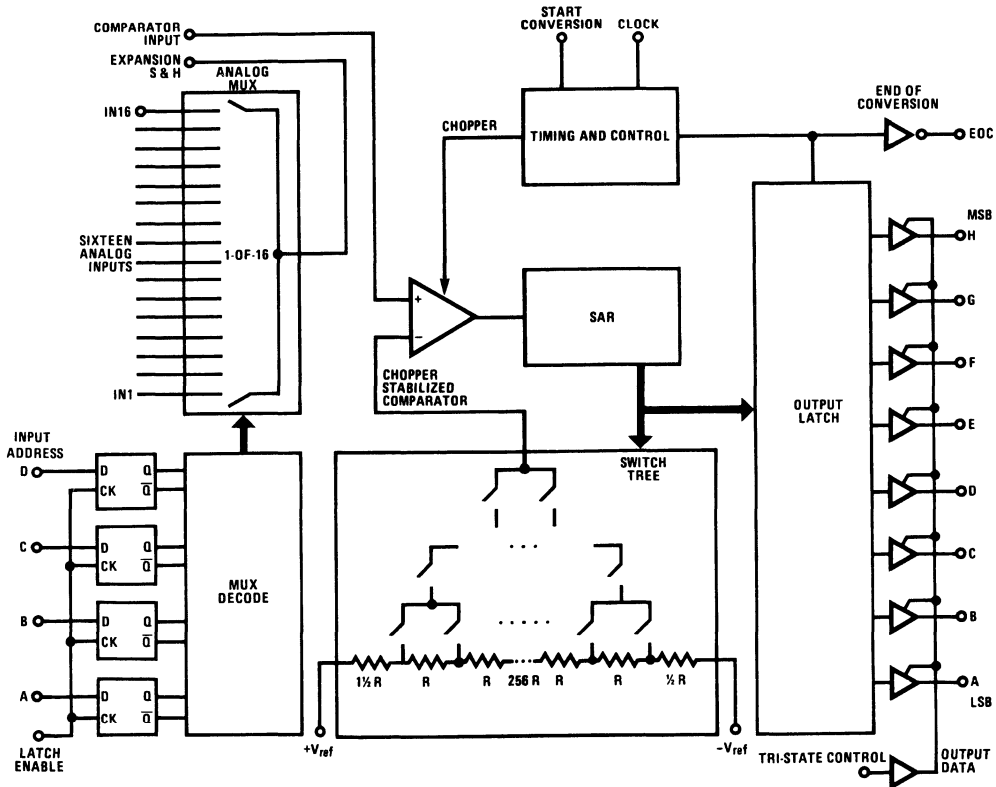


FIGURE 1. ADC0816/MM74C948 Block Diagram

TL/H/7207-1

Figure 2 shows a typical application employing the ADC0816 for use in a microprocessor-based environmental control system. In this system the microprocessor can select a channel, monitor a particular sensor reading, convert that signal to a digital word, and make a system decision based upon that input. Many other areas of process control, machine control, or multi-input analog system can utilize this basic configuration.

THE CONVERTER

The heart of this single-chip data acquisition system is its 8-bit analog-to-digital converter. The converter is designed to give fast, accurate, and repeatable conversions over a wide range of temperatures. The converter is partitioned into three major sections: the 256R ladder network, the successive approximation register, and the comparator.

The 256R ladder network approach was chosen over the conventional R/2R ladder because of its inherent monotonicity. Monotonicity is particularly important in closed-loop feedback control systems. A non-monotonic relationship can cause oscillations that could be catastrophic. Additionally, the 256R network does not cause load variations on the reference voltage.

Figure 3 shows a comparison of the output characteristic for the two approaches with a variation in the ladder resistance. In the 256R approach with unequal or shorted resistors the slope of the output transfer function cannot be different from the slope of the analog input. For the R/2R ladder network, mismatches in the resistor values can cause the slope of the output digital code to be different from the analog input signal.

The bottom resistor and the top resistor of the ladder network in Figure 4 are not the same value as the remainder of the network. The difference in these resistors causes the output characteristic to be symmetrical with the zero and full-scale points of the transfer curve. The first output transition occurs when the analog signal has reached $+1/2$ LSB and succeeding output transitions occur every 1 LSB later up to full-scale.

The successive approximation register (SAR) performs eight iterations to approximate the input voltage. For any SAR-type converter, n iterations are required for an n -bit converter. Figure 4 shows a typical example of a 3-bit converter with an input voltage of $1/4$ full-scale. Since the initial approximation at $7/16$ of full-scale is too high, a zero is posted for the most significant bit (MSB). The second approximation is too low, therefore a one is posted for the second bit. The final approximation is determined to be too high, so a zero is posted for the least significant bit (LSB). In the ADC0816/MM74C948 the approximation technique is extended to eight bits using the 256R network.

The most important section of the A/D converter is the comparator. It is this section which is responsible for the ultimate accuracy of the entire converter. It is also the comparator drift which has the greatest influence on the respectability of the device. A chopper stabilized comparator provides the most effective method of satisfying all the converter requirements.

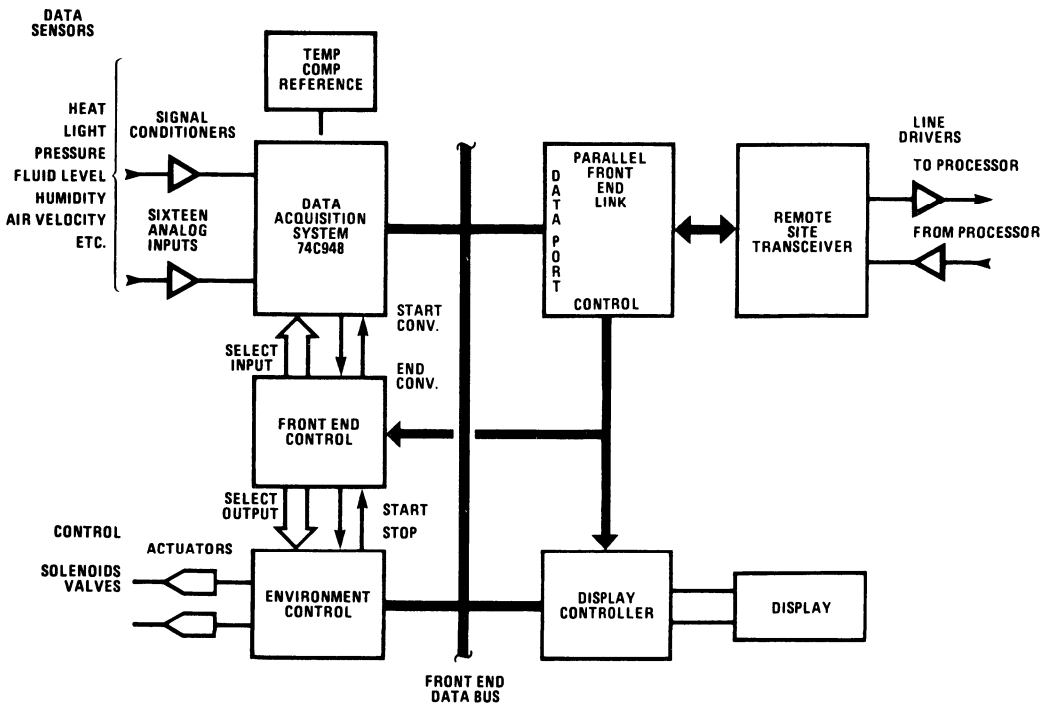
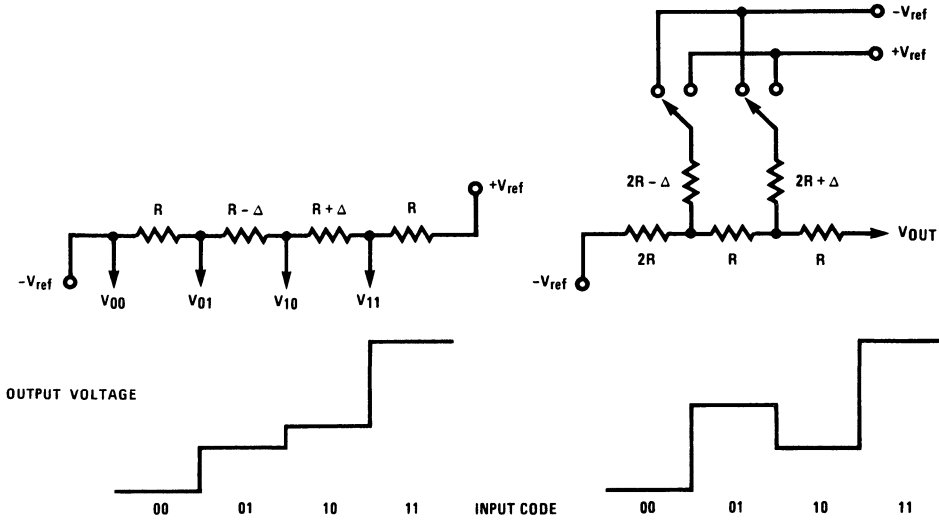


FIGURE 2. Remote Environmental Control System

TLH/7207-2

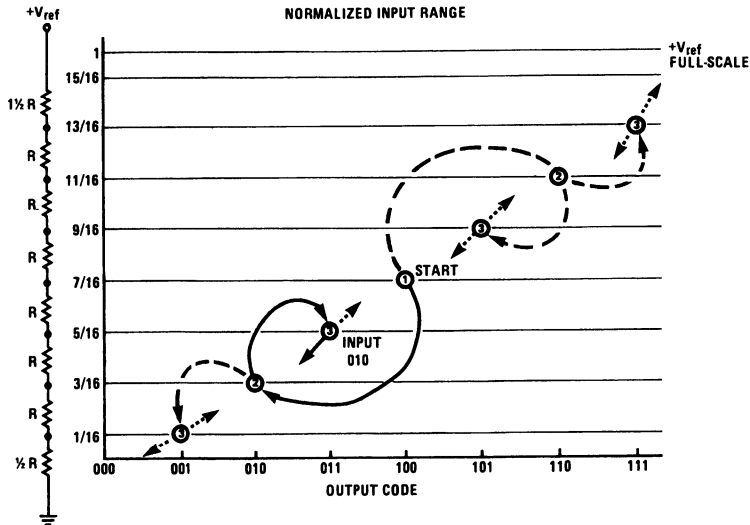
The chopper stabilized comparator converts the DC input signal into an AC signal. This signal is then fed through a high gain AC amplifier and has the DC level restored. This technique limits the drift component of the amplifier since the drift is a DC component which is not passed by the AC amplifier. This makes the entire A/D converter extremely insensitive to temperature, long-term drift, and input offset errors.

The design of this A/D converter has been optimized by incorporating the most desirable aspects of several conversion techniques. The ADC0816 offers high speed, high accuracy, low temperature dependence, excellent long-term accuracy and repeatability, and consumes minimal power. These features make this device ideally suited to applications such as process control, industrial control, and machine control.



TL/H/7207-3

FIGURE 3. 2^nR and R2R Ladder Transfer Curves. In a 2^nR ladder the most unequal resistors can do is cause a nonuniform voltage step. Since a single voltage is across the ladder it must be monotonic. In a R2R ladder unequal resistors may cause a sign change in the transfer curve, causing it to be nonmonotonic.



TL/H/7207-4

FIGURE 4. Offset-Adjusted 8R Ladder gives $\pm \frac{1}{2}$ LSB quantizing error of 3 bits with three comparisons. The output code is derived by posting a one when upward arrows are followed and a zero when downward arrows are followed to the input voltage.

CMOS A/D Converter Chips Easily Interface to 8080A Microprocessor Systems

National Semiconductor
Application Note 200



AN-200

SUMMARY

This paper describes techniques for interfacing National Semiconductor's new ADC3511 and ADC3711 microprocessor compatible analog-to-digital converter chips to 8080A microprocessor systems. The hardware interface and the software interrupt service routine will be described for single and multiple A/D converter data acquisition systems.

INTRODUCTION

The recent introduction of monolithic digital voltmeter chips has encouraged designers to consider their use as analog-to-digital converters in data acquisition systems. While the high accuracy afforded at low cost was attractive, certain difficulties in applying these devices in digital systems were encountered. Most of these difficulties were due to the DVM chip's output structure being oriented towards driving 7-segment displays with internally generated digit scanning rates. National Semiconductor has recently introduced a family of monolithic CMOS A/D converters—2 of these devices are directed towards LED display DPM and DVM applications (ADD3501 3 1/2-digit DPM and ADD3701 3 3/4-digit DPM) while the other 2 (ADC3511 3 1/2-digit A/D and ADC3711 3 3/4-digit A/D) have addressable BCD outputs. These last 2 devices allow easy interface to microprocessor and calculator-oriented (COPS) systems.

Single or multiple channel monitoring of physical variables can be achieved with high accuracy despite the lack of complexity and low overall cost.

A/D CONVERSION

All A/D converters in this family operate from a single 5V supply and convert inputs from 0 to $\pm 2V$. The converters use a pulse-width modulation technique which requires no precision components and exhibits low offset, low drift, high linearity and no rollover error. An additional advantage is that the voltage reference is of the same polarity as the supply.

Two resolutions are offered: the 3 1/2-digit types divide the input into 2,000 counts plus sign, while the 3 3/4-digit types provide 4,000 counts plus sign which is roughly equivalent to the resolution of a 12-bit plus sign binary converter. The 3 1/2-digit converters require 200 ms per conversion; 3 3/4-digit types require 400 ms.

The converters handle negative inputs by internally switching the inputs and forcing the sign bit low. While this technique allows conversion of positive and negative inputs with only a single supply, the supply must be isolated from the inputs. Without an isolated supply, only positive voltages may be converted.

The basic converter is shown in Figure 1. The actual conversion technique is described in Appendix A.

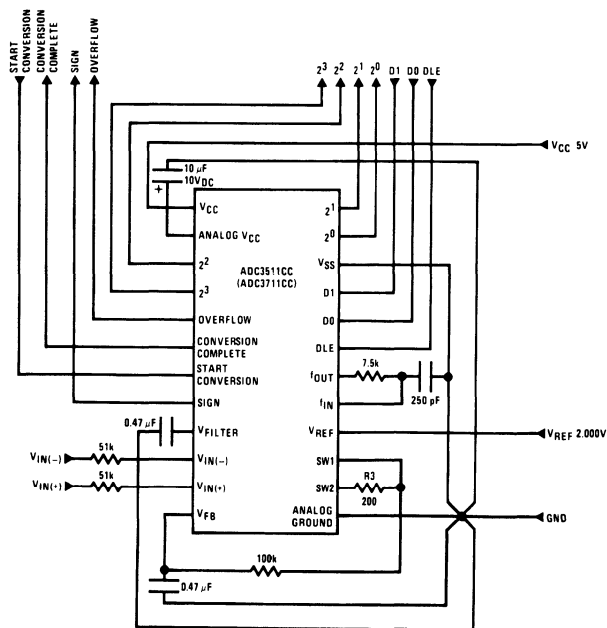


FIGURE 1. Basic A/D Converter

TL/H/5616-1

BCD OUTPUT DESCRIPTION

The ADC3511 and ADC3711 present the output data in BCD form on a single 4-line output port, plus a separate sign output. The desired digit is selected by a 2-bit address which is latched by a high level at the Digit Latch Enable input (DLE); a low level at DLE allows flow thru operation. Since the output is BCD, it is compatible with many standard instruments and can easily be converted into binary by the processor if this format should be desired. Overrange inputs are indicated by a hexadecimal "EEEE" plus an Overflow output.

A new conversion is begun by a positive pulse or high level at the Start Conversion (SC) input. The analog section of the converter continuously tracks the analog input. The Start Conversion command controls only the transfer of new data to the output latches, consequently the delay from the SC pulse to the Conversion Complete (CC) signal may vary from several milliseconds to several hundred milliseconds. In interrupt driven systems the delay is no problem, since the processor does not execute delay instructions while waiting for the data. However, if in-line or program I/O is used where the program waits for the data to be ready, the maximum delay between SC and CC must be programmed into the wait routine. This type of I/O is therefore not as efficient as interrupt I/O.

The CC output goes low immediately after the SC pulse. At the end of a conversion, CC goes high and remains high until a new conversion is initiated. Continuous conversion operation is obtained by tying the SC input to V_{CC} .

REFERENCE VOLTAGE

The 2.000V reference is derived from the LM336, a recently announced monolithic reference which provides 2.5V with low drift at low cost. This active reference is adjusted for minimum thermal drift of about 20 ppm/°C by using a third terminal on the device to adjust its output to 2.490V.

Total reference current consumption is low, as the LM336 requires only 1 mA of bias current, and the resistor divider about 2 mA. The reference circuit is shown in *Figure 2*.

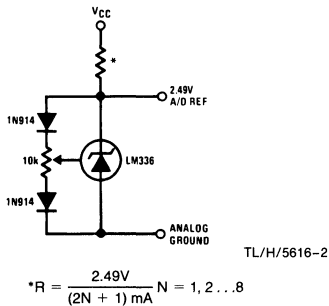


FIGURE 2. A/D Converter Reference. The 10k Pot is Adjusted to a Voltage of 2.49V on the Output; at this Voltage Minimum Drift Occurs. The Reference can Supply up to 8 A/D Converters.

One reference can be used for many A/D's. The values of the upper series resistor R1 depends on the number of converters used.

A SINGLE CHANNEL CONVERTER

A complete A/D port is seen in *Figures 3* and *4*. *Figure 3* shows a Dual Polarity converter and *Figure 4* a Positive Only Polarity converter. Each port contains an A/D converter, TRI-STATE® bus driver, and 2 gates to control I/O. This A/D port is easily used in single or multi-channel systems. In multichannel systems a converter is used on every channel allowing digital multiplexing of the outputs.

Data from the A/D converter in a single channel system is easily processed using an OUT command to start a conversion and IN commands to read the data after the microprocessor has been interrupted by a Conversion Complete.

As seen in *Figure 5*, a single channel A/D port uses a 6-bit bus comparator to decode its assigned peripheral address from the lower address bits of the 8080A address bus.

When an interrupt is received, the present status of the processor is stored on the stack memory by a series of push commands. The interrupt is serviced by reading digit 4 (MSD) into the processor and checking the overflow bit. If the overflow bit is high, the converter input has exceeded its range and an error signal is generated, indicating that scaling must be done to attenuate the input signal. If the OFL is low, the sign bit is then checked to determine the polarity of the conversion. If the sign bit is low, a "1" is added to the MSB of digit 4. Since this bit would normally be low, (maximum converter range allows $MSB \leq 3$ or 0011) a "1" in this position is used to denote a negative input voltage. The 4 bits of digit 4 which now include the sign are shifted into the upper half of the first byte and the 4 bits of digit 3 are packed into the lower half. Similarly, digits 2 and 1 are packed into the second byte and both bytes stored in memory.

Figure 6 and routine 1 are the flow chart and assembly language routine used to implement this action.

8-CHANNEL A/D WITH SOFTWARE PRIORITY

The basic A/D port can easily be expanded to multiple channel systems. An 8-channel system is seen in *Figure 7*. This system interrupts the processor when one of the Conversion Complete outputs goes high. The processor saves the current status and reads the status word of the A/D system. The status word is then compared to a priority table. Each level in the table corresponds to a priority level with high priority converters which are first in the table. If 2 or more converters have the same priority and are ready at the same time, the converter with the highest number gets serviced first.

The program determines which service routine to use by the bit position of "1's" in the status word. The routine loads the address pointer to digit 4 of the selected converter. The

program then calls a subroutine which goes through the process of checking overflow, sign and packs 4 BCD digits into 2 bytes. These 2 bytes are then stored in a table in the memory directly above the converter addresses. After a

channel is serviced, the original processor status is restored and the interrupt enabled. If additional channels need service, they immediately interrupt so the new status word is then read and a new priority established.

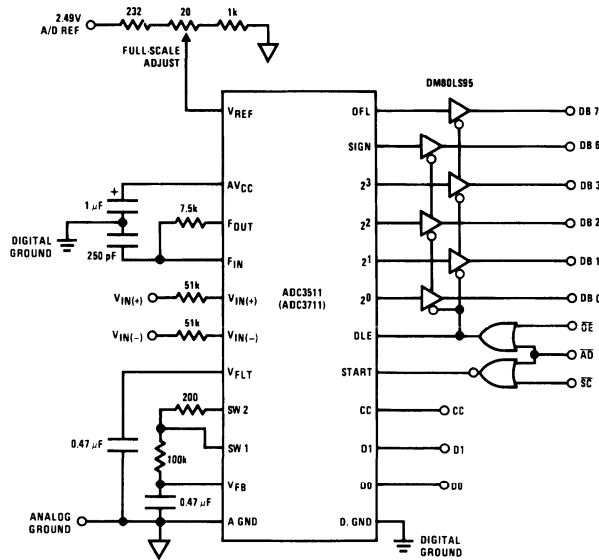


FIGURE 3. Dual Polarity A/D Requires that Inputs are Isolated from the Supply. Input Range Is $\pm 1.999V$.

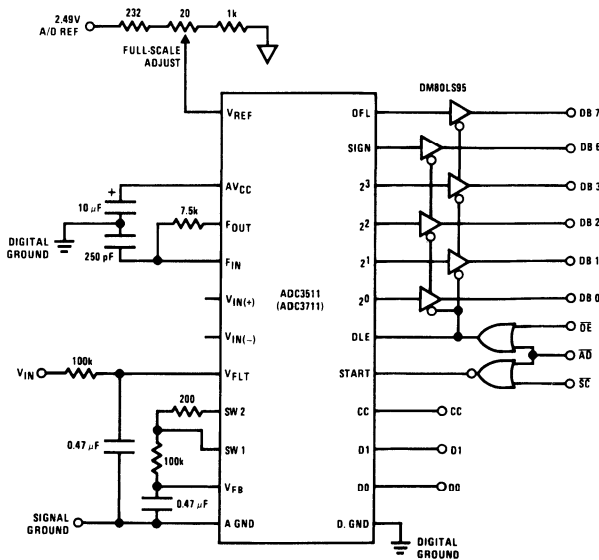


FIGURE 4. Positive Polarity A/D Operating from 5V Supply. Input Range Is $+ 1.999V$.

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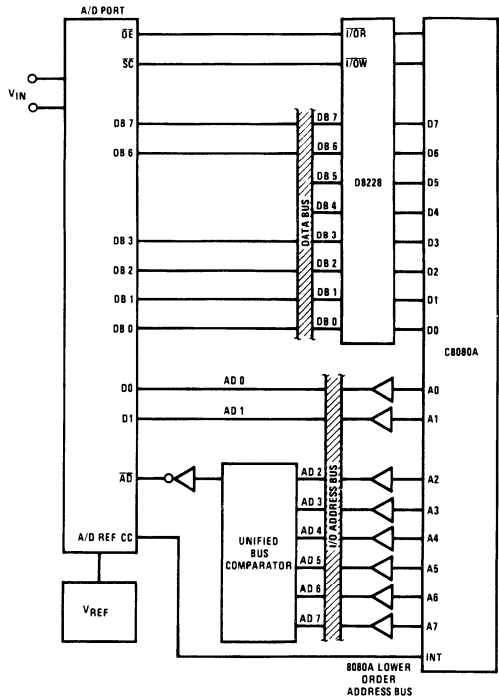


FIGURE 5. Single Channel A/D Interface with Peripheral Mapped I/O

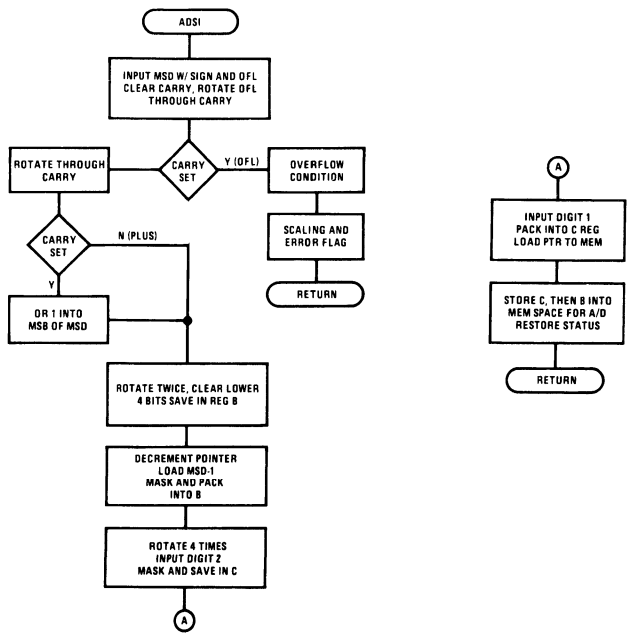


FIGURE 6. Flow Chart for Single Channel A/D Converter

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Routine 1. Single Channel Interrupt Service Routine

LABEL	OPCODE	OPERAND	COMMENT	LABEL	OPCODE	OPERAND	COMMENT
ADIS:	PUSH	PSW	; A/D interrupt service		IN	ADD 2	; delay
					RAL		; rotate
	PUSH	H	; save		RAL		; into
	PUSH	B	; current status		RAL		; upper
	IN	ADD 4	; input A/D digit 4		RAL		; 4 bits
	IN	ADD 4	; delay		ANI	FO	; mask lower bits
	ORA		; reset carry		MOV	C, A	; save in C
	RAL		; rotate OFL thru carry		IN	ADD 1	; in digit 1
	JC	OFL	; overflow condition		IN	ADD 1	; delay
	RAL		; rotate sign thru carry		ANI	OF	; mask upper bits
	JC	PLUS	; positive input		OR	C	; pack
	ORI	20H	; OR 1 into MSB, neg input		MOV	C, A	; save in C
					LXI	H, ADMS	; load ptr to A/D Mem, space
PLUS:	RAL		; shift		MOV	M, C	; save C in memory
	RAL		; into position		INX	H	; point next
	ANI	FO	; mask lower bits		MOV	M, B	; save B in memory
	MOV	BA	; save in B		OUT	ADD 1	; start new conversion
	IN	ADD 3	; input digit 3		POP	B	; restore
	IN	ADD 3	; delay		POP	H	; previous
	ANI	OF	; mask higher bits		POP	PSW	; status
	OR	B	; pack into B		EI		; enable interrupts
	MOV	B, A	; save in B		RET		; return to main program
	IN	ADD 2	; input digit 2				

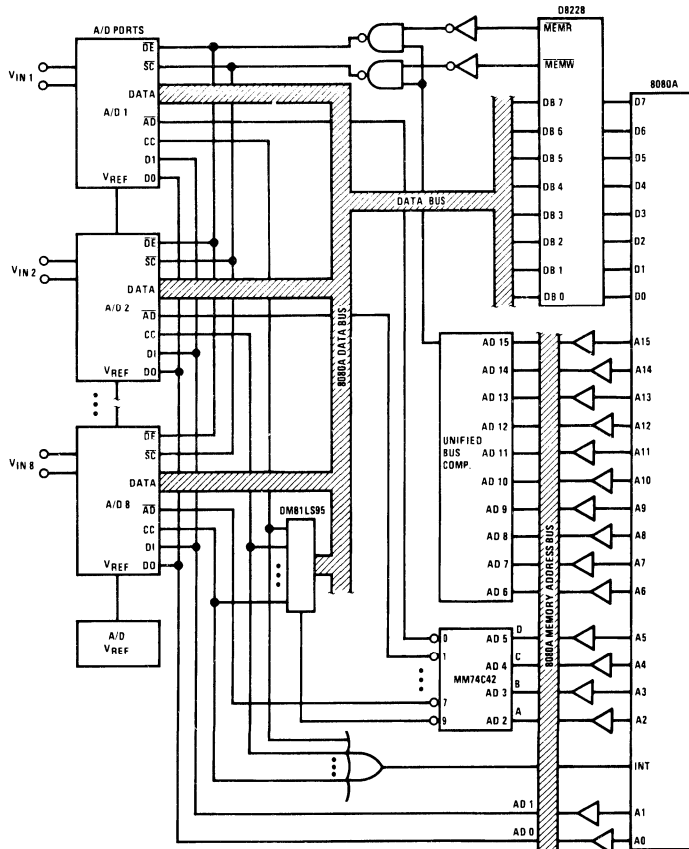


FIGURE 7. 8-Channel A/D System with Maskable Priority Interrupt Using Memory Mapped I/O

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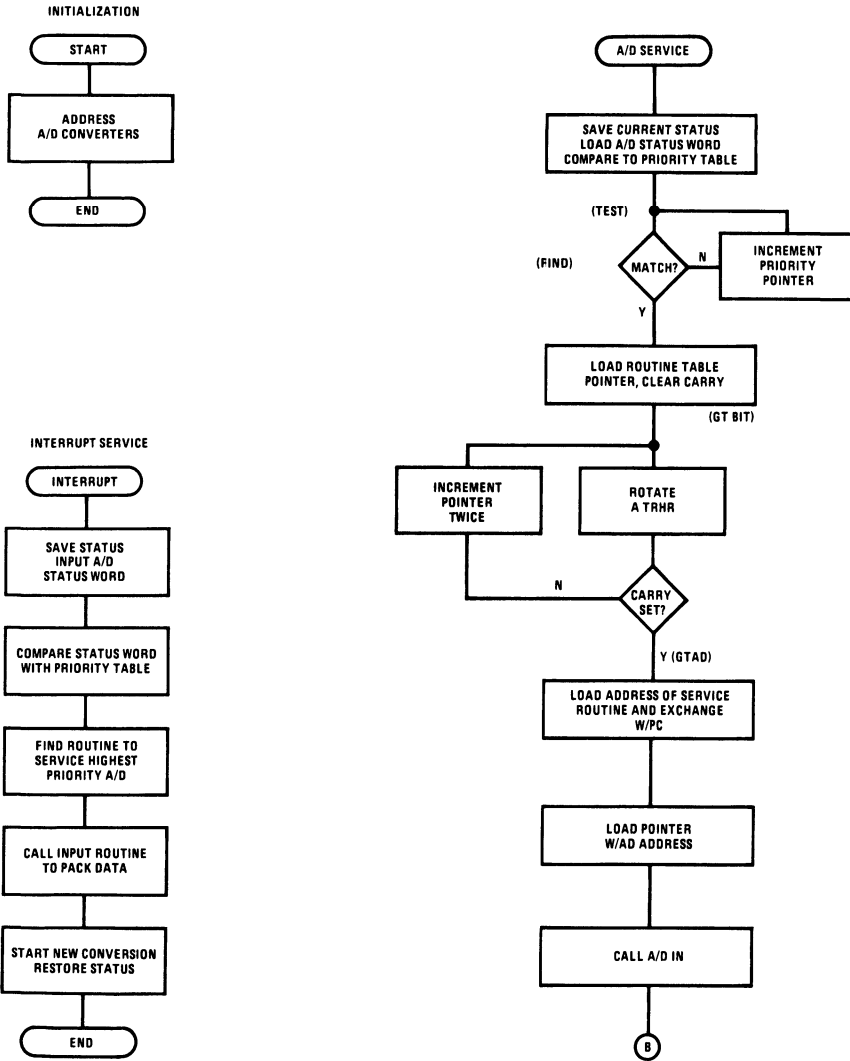


FIGURE 8. Flow Charts of A/D Routines

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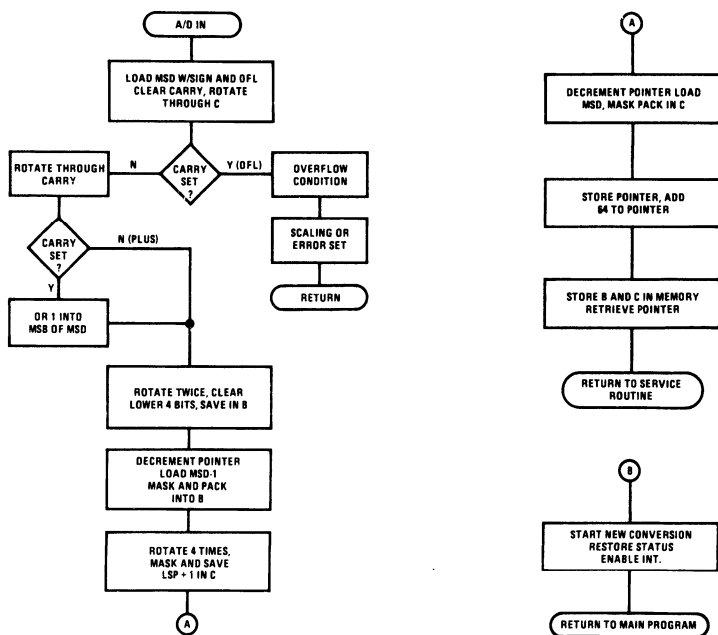


FIGURE 8. Flow Charts of A/D Routines (Continued)

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Routine 2. 8-Channel Interrupt Service Routine with Software Priority

LABEL	OPCODE	OPERAND	COMMENT	LABEL	OPCODE	OPERAND	COMMENT
IAD:	PUSH	PSW	; interrupt from A/D		XCGH		; exchange DE, HL
	PUSH	H	; save H & L on stack		PCHL		; jump to input routine
	PUSH	B	; save B & C on stack	INAD1:	LXI	H, AD1	; pickup pointer to A/D 1
	PUSH	D	; save D & E on stack		CALL	ADIN	; call common input routine
	LXI	H, ADWD	; pickup A/D status word		MOV	M, A	; start new conversion
	MOV	6, M	; move word into B		JMP	DONE	; all done
	LXI	H, PRTBL	; pickup priority tbl pointer	INAD2:	LXI	H, AD2	; pickup pointer to A/D 2
TEST:	MOV	A, B	; place status word in accum.		CALL	ADIN	; call input routine
	ANA	M	; mask with priority table		MOV	M, A	; start new conversion
	JNZ	FIND	; match jump to Find		JMP	DONE	; all done
	INX	H	; point to lower priority				
	JMP	TEST	; try again	DONE:	POP	D	; restore D
FIND:	LXI	H, RTBL	; pickup routine tbl pointer		POP	B	; restore B
					POP	H	; restore H
GTBIT:	ORA	A	; reset carry		POP	PSW	; restore PSW
	RAR		; rotate thru carry		EI		; enable interrupts
	JC	GTAD	; bit was found		RET		; return to main program
	INX	H	; point to	PRTBL:	DB	04H	; 0000C100 AD3 highest priority
	INX	H	; next routine		DB	03H	; 0000011 AD2 & AD1 next priority
GTAD:	JMP	GTBIT	; try again				
	MOV	E, M	; move first byte into E				
	INX	H	; point to next byte				
	MOV	D, M	; move second byte into D				

Routine 2. 8-channel Interrupt Service Routine with Software Priority (Continued)

LABEL	OPCODE	OPERAND	COMMENT	LABEL	OPCODE	OPERAND	COMMENT
PRTBL:	DB	10H	; 00010000 AD5 lowest priority		MOV	B, A	; save in B
					DCR	H	; point to LSD + 1
RTBL:	DW	1000H	; routine for A/D 1		MOV	A, M	; input LSD + 1
	DW	100CH	; routine for A/D 2		MOV	A, M	; delay
	•				RAL		; rotate
	•				RAL		; into
	•				RAL		; upper
	DW	1060H	; routine for A/D 8		RAL		; 4 bits
ADIN:	MOV	A, M	; Input MSD plus OFL & SIGN		ANI	FO	; mask lower bits
	MOV	A, M	; delay		MOV	C, A	; save in C
	ORA	A	; reset carry		DCR	H	; point to LSD
	RAL		; rotate left thru carry, OFL		MOV	A, M	; input LSD
	JC	OFL	; jump to overflow if set		MOV	A, M	; delay
	RAL		; rotate left thru carry, sign		ANI	OF	; mask upper bits
	JC	PLUS	; jump to plus if set		OR	C	; pack
	OR1	20H	; OR1 into BCD, MSB for minus		MOV	C, A	; save in C
					SHLD	TEMP	; store HL in temp
					MOV	A, L	; move L in accum.
					ACI	64	; generate lower address
PLUS:	RAL				MOV	L, A	; above memory mapped
	RAL				MOV	A, H	; converter addresses
	ANI	FO	; mask lower order bits		ACI	O	; include carry
	MOV	B, A	; save in B		MOV	H, A	; to upper bits
	DCR	H	; point to MSD-1		MOV	M, C	; store C
	MOV	A, M	; input MSD-1		INX	H	; then
	MOV	A, M	; delay		MOV	M, B	; store B
	ANI	OF	; mask higher 4 bits		LHLD	TEMP	; retrieve HL
	OR	B	; pack MSD and MSD-1		RET		; return

ADJUSTMENT AND TESTING

Adjustment and testing of a single channel A/D is done by monitoring the memory space where the interrupt routine stores the data word. The microprocessor is forced to loop around a section of program with interrupts enabled. As the input voltage of the converter is changed, this data word should also change as the converter updates it. A precision voltage reference is connected to the input of the A/D and incremental voltage steps are applied. The A/D data word should also change according to the voltage steps.

At full-scale input voltage, the data word should be at its maximum value. If not, check the full-scale adjust on the A/D by adjusting it so the OFL bit goes high when the input is exactly 2.000V.

Multichannel systems are more difficult to check. Start by individually checking the full-scale adjustments so the converters overflow at 2.000V. Check the software priority routine by forcing all status bits of the status word high. This corresponds to all converters being ready at the same time, a very unlikely worst-case condition. The microprocessor should respond by outputting the address of all 4 digits of the A/D port with the highest priority along with the memR strobes, then with a memW strobe to start a new conversion. The next highest priority converter should then receive its addresses and memR strobes and so on down the line.

Once the priority routine has been debugged, each data word is monitored as the input to its converter is adjusted. Since a common input routine is used, once 1 channel operates, all the other channels should also.

Debugging may most easily be done by single stepping through the program at these critical areas. No timing problems should be encountered since the A/D port appears to be a standard peripheral or memory. In the ADC3511 and ADC3711 the desired output is merely addressed the same as a memory location.

The memory requirements of the interface depends, of course, on the complexity of the system. The single channel converter requires approximately 60 bytes of program storage plus 2 bytes for data storage and 4 peripheral addresses.

The multichannel system requires about 40 bytes for the priority routine and 10 bytes of program for each converter routine. The common input routine requires about 50 bytes of program and is used by all the converter routines in the form of a subroutine.

Memory mapped I/O causes 64 memory locations to be used to input an 8-channel system. The data space is located directly above the address space for the converters and 16 memory locations are used to store the data for 8 converters.

CONCLUSION

The ADC3511 and ADC3711 microprocessor compatible A/D converters eliminate the difficulties previously encountered in applying DPM chips to microprocessor systems. The low parts count and low cost per channel make distributed or remote A/D conversion practical for a variety of data acquisition applications.

**APPENDIX A
THEORY OF OPERATION**

A schematic for the analog loop is shown in *Figure A1*. The output of SW 1 is either at V_{REF} or 0V, depending on the state of the D flip-flop. If Q is at a high level, $V_{OUT} = V_{REF}$ and if Q is at a low level $V_{OUT} = 0V$. This voltage is then applied to the low pass filter comprised of R1 and C1. The output of this filter, V_{FB} , is connected to the negative input of the comparator, where it is compared to the analog input voltage, V_{IN} . The output of the comparator is connected to the D input of the D flip-flop. Information is then transferred from the D input to the Q and \bar{Q} outputs on the positive edge of clock. This loop forms an oscillator whose duty cycle is precisely related to the analog input voltage V_{IN} .

An example will demonstrate this relationship. Assume the input voltage is equal to 0.500V. If the Q output of the D flip-flop is high, then V_{OUT} will equal V_{REF} (2.000V) and V_{FB} will charge toward 2V with a time constant equal to $R1C1$. At some time V_{FB} will exceed 0.500V and the comparator output will switch to 0V. At the next clock rising edge, the Q output of the D flip-flop will switch to ground, causing V_{OUT} to switch to 0V. At this time, V_{FB} will start discharging toward 0V with a time constant $R1C1$. When V_{FB} is less than 0.5V, the comparator output will switch high. On the rising edge of the next clock, the Q output of the D flip-flop will switch high and the process will repeat. There exists at the output of SW 1 a square wave pulse train with positive amplitude V_{REF} and negative amplitude 0V.

The DC value of this pulse train is:

$$V_{OUT} = V_{REF} \frac{t_{ON}}{t_{ON} + t_{OFF}} = V_{REF} (\text{duty cycle})$$

The low pass filter will pass the DC value and then:

$$V_{FB} = V_{REF} (\text{duty cycle})$$

Since the closed loop system will always force V_{FB} to equal V_{IN} , we can then say that:

$$V_{IN} = V_{FB} = V_{REF} (\text{duty cycle})$$

or

$$\frac{V_{IN}}{V_{REF}} = (\text{duty cycle})$$

The duty cycle is logically ANDed with the input frequency f_{IN} . The resultant frequency f equals:

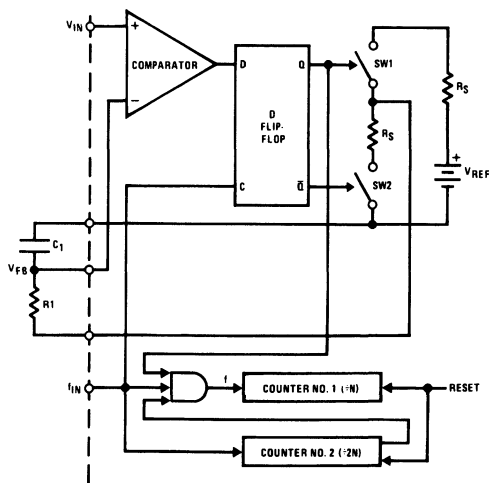
$$f = (\text{duty cycle}) \times (f_{IN})$$

Frequency f is accumulated by counter no. 1 for a time determined by counter no. 2. The count contained in counter no. 1 is then:

$$\text{count} = \frac{f}{(f_{IN}/N)} = \frac{(\text{duty cycle}) \times (f_{IN})}{(f_{IN}/N)} = \frac{V_{IN}}{V_{REF}} \times N$$

For the ADC3511 $N = 2000$.

For the ADC3711 $N = 4000$.



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$$V_{IN} = V_{FB} = V_{REF} \times (\text{duty cycle})$$

$$f = (\text{duty cycle}) \times f_{IN}$$

$$\text{Count in Counter No. 1} = \frac{f}{f_{IN}/N} = \frac{(\text{duty cycle}) \times f_{IN}}{f_{IN}/N} = \frac{V_{IN}}{V_{REF}} \times N$$

FIGURE A1. Analog Loop Schematic Pulse Modulation A/D Converter

Electrical Characteristics

ADC3511CC, ADC3711CC $4.75 \leq V_{CC} \leq 5.25V$; $-40^{\circ}C \leq T_A + 85^{\circ}C$, $f=5$ conv./sec (ADC3511CC); 2.5 conv./sec (ADC3711CC); unless otherwise specified.

Parameter	Conditions	Min	Typ (Note 2)	Max	Units
Non-Linearity	(Note 3) $V_{IN} = 0-2V$ Full-Scale $V_{IN} = 0-200$ mV Full-Scale	-0.05	+0.025	0.05	% of Full-Scale
Organization Error		-1		0	Counts
Offset Error	$V_{IN} = 0V$, (Note 4)	-0.5	1.0	3.0	mV
Rollover Error		-0		0	Counts
V_{IN+} , V_{IN-} Analog Input Current	$T_A = 25^{\circ}C$	-5	1	5	nA

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All typicals are given for $T_A = 25^{\circ}C$.

Note 3: For the ADC3511CC: full-scale = 1999 counts; therefore, 0.025% of full-scale = $\frac{1}{2}$ counts and 0.05% of full-scale = 1 count. For the ADC3711CC: full-scale = 3999 counts; therefore, 0.025% of full-scale = 1 count and 0.05% of full-scale = 2 counts.

Note 4: For full-scale = 2.000V: 1 mV = 1 count for the ADC3511CC; 1 mV = 2 counts for the ADC3711CC.

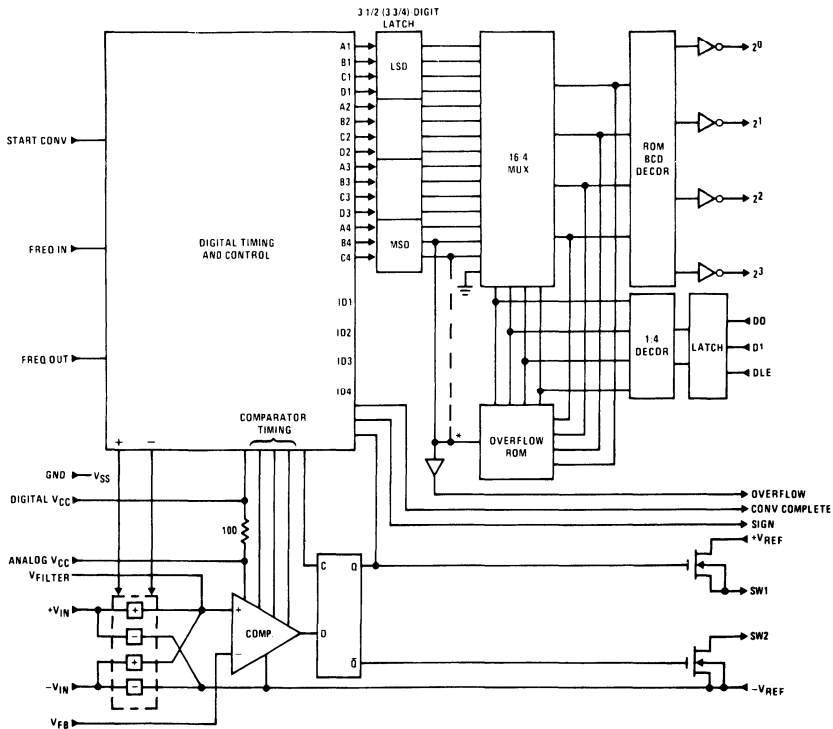


FIGURE A2. ADC3511 3 1/2-Digit A/D (*ADC3711 3 3/4-Digit A/D) Block Diagram

TL/H/5616-9

A Digital Multimeter Using the ADD3501

National Semiconductor
Application Note 202



AN-202

INTRODUCTION

National Semiconductor's ADD3501 is a monolithic CMOS IC designed for use as a 3 $\frac{1}{2}$ -digit digital voltmeter. The IC makes use of a pulse-modulation analog-to-digital conversion scheme that operates from a 2V reference voltage, functions with inputs between 0V and $\pm 1.999V$ and operates from a single supply.

The conversion rate is set by an external resistor/capacitor combination, which controls the frequency of an on-chip oscillator. The ADD3501 directly drives 7-segment multiplexed LED displays, aided only by segment resistors and external digit buffers. The ADD3501 blanks the most significant digit whenever the MSD is zero; and, during overrange conditions, the display will read either +OFL or -OFL (depending on the polarity of the input.)

These characteristics make the ADD3501 suitable for use in low-cost instrumentation. An example of such use is the inexpensive, accurate, digital multimeter (DMM) presented here—an instrument that measures AC and DC voltages and currents, and resistance.

CIRCUIT DESCRIPTION

Figure 1 shows the circuit diagram of the ADD3501-based DMM, and Table I summarizes its measurement capabilities. Since the accuracy of the ADD3501 is $\pm 0.05\%$, the DMM's performance is mainly determined by the choice of discrete components.

Supporting the ADD3501 is a DS75492 digit driver, an NSB5388 LED display, and an LM340 regulator for the V_{CC} supply. A 2V reference voltage—derived from the LM336 reference-diode circuitry—permits the 3 $\frac{1}{2}$ -digit system a 1 mV/LSD resolution (i.e., the ADD3501's full-scale count of 1999 or 1999 mV).

DC Voltage Measurement. The DMM's user places the (+) and (-) probes across the voltage to be measured, and sets the voltage range switch as necessary. This switch scales the input voltage, dividing it down so that the maximum voltage across the ADD3501's V_{IN} and V_{IN} —pins is limited to 2V full-scale on each input range. The ADD3501 performs an A/D conversion, and displays the value of the DMM's input voltage. The instrument's input impedance is at least 10 M Ω on all DC voltage ranges. Except for the 2V range, the DMM's survival voltage—the maximum safe DC input—is in excess of 1 kV. On the 2V range, the maximum allowable input is 700V.

AC Voltage Measurement. Switching the DMM to its AC VOLTS mode brings the circuit of Figure 2 into function. This circuit operates as an averaging filter to generate a DC output proportional to the value of the rectified AC input; this value, in turn, is "tapped down" by R5 to a level equivalent to the input's rms value, which is the value displayed by the DMM.

Op amp A3 is simply a voltage follower that lowers the input-attenuator's source impedance to a value suitable to drive into A4. This impedance conversion helps eliminate some of the possible offset-voltage problems (the A4 input-offset-current source impedance IR drop, for example) and noise susceptibility problems as well. C1 blocks the DC offset voltage generated by A3.

A4 and A5 comprise the actual AC-to-DC converter; to see how it works refer again to Figure 2, and consider first its operation on the negative portion of an AC input signal. At the output of A4 are 2 diodes, D1 and D2, which act as switches. For a negative input to A4's inverting input, D1 turns on and clamps A4's output to 0.7V, while D2 opens, disconnecting A4's output from A5's summing point (the inverting input). A5 now operates as a simple inverter: R2 is its input resistor, R5 its feedback resistor, and its output is positive.

Now consider what happens during the positive portion of an AC input. A4's output swings negative, opening D1 and closing D2, and the op amp operates as an inverting unity-gain amplifier. Its input resistor is R1, its feedback resistor is R3, and its output now connects to A5's summing point through R4. D2 does not affect A4's accuracy because the diode is inside the feedback loop.

A positive input to A4 causes it to pull a current from A5's summing point through R4 and D2; the positive input also causes a current to be supplied to the A5 summing point through R2. Because A4 is a unity-gain inverter, the voltage drops across R2 and R4 are equal, but opposite in sign. Since the value of R2 is double that of R4, the net input current at A5's summing point is equal to, but opposite, the current through R2. A5 now operates as a summing inverter, and yields—again—a positive output. (R6 functions simply to reduce output errors due to input offset currents.)

Thus, the positive and negative portions of the DMM's AC voltage input both yield positive DC outputs from A5. With C2 connected across R5 as shown, the circuit becomes an averaging filter. As already mentioned, the tap on R5 is set so that the circuit's DC output is equivalent to the rms value of the DMM's AC voltage input, which is the value converted and displayed by the ADD3501

DC Current Measurement. To make a DC current measurement, the user inserts the DMM's probes in series with the circuit current to be measured and selects a suitable scale. On any scale range, the DMM loads the measured circuit with a 2V drop for a full-scale input.* The ADD3501 simply converts and displays the voltage drop developed across the DMM's current-sensing resistor.

*This drop may be reduced to 200 mV; refer to the last section of this application note.

TECHNICAL SPECIFICATIONS

DC VOLTS RANGES

- < ±1% ACCURACY
- 2V, 20V, 200V, 2 kV
- INPUT IMPEDANCE
- 2V RANGE, > 10MΩ
- 20V TO 2 kV RANGE, 10MΩ

AC RMS VOLTS RANGES

- < ±1% ACCURACY
- 2V, 20V, 200V, 2 kV
- (40 TO 5 kHz SINEWAVE)

DC AMPS RANGES

- < ±1% ACCURACY
- 200 μA, 2mA, 20 mA, 200 mA, 2A

AC RMS AMPS RANGES

- < ±1% ACCURACY
- 200 μA, 2 mA, 20 mA, 200 mA, 2 A

OHMS RANGES

- < ±1% ACCURACY
- 200 Ω, 2 kΩ, 20 kΩ, 200 kΩ, 2 MΩ

Note 1: All VCC connections should use a single VCC point and all ground/ analog ground connections should use a single ground/analog ground point.

Note 2: All resistors are 1/4 watt unless otherwise specified.

Note 3: All capacitors are ±10%.

Note 4: All op amps have a 0.1 μF capacitor connected across the V+ and V- supplies.

Note 5: All diodes are 1N914.

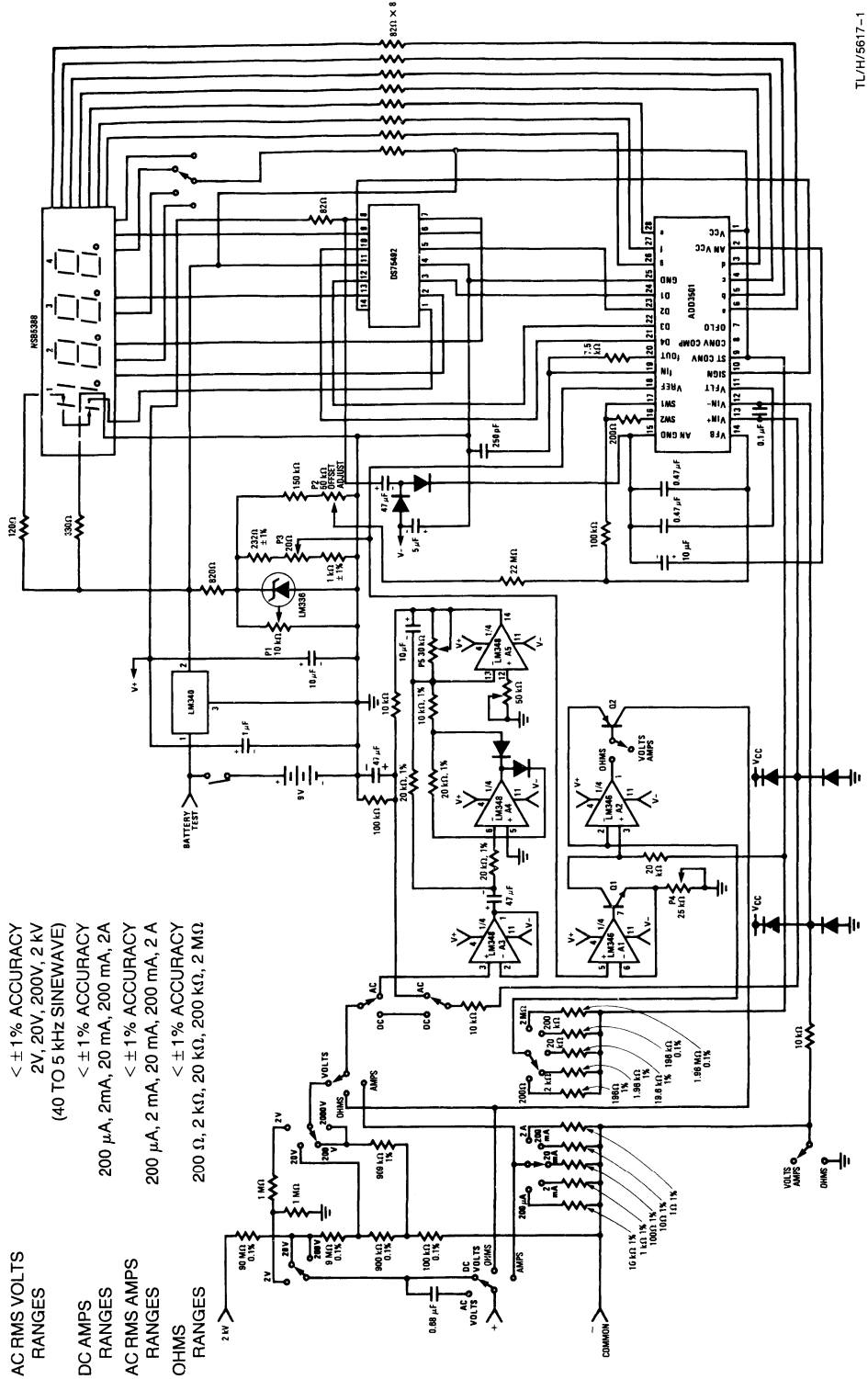


FIGURE 1. ADD3501 Low Cost Digital Multimeter

AC Current Measurement. AC current measurements are made in a way similar to DC current measurements. The DMM is switched to its AMPS and AC settings. The in-circuit current is again measured by a drop across the DMM's current-sensing resistor, but now the AC voltage developed across this resistor is processed by A3, A4, and A5—exactly as described for AC voltage measurements—before being transferred to the ADD3501. Again, the DMM displays an rms value appropriate for the AC signal current being measured.

Resistance Measurement. This DMM measures resistance in the same way as do most multimeter: it measures the voltage drop developed across the unknown resistance by forcing a known, constant-current through it. Suitable scale calibration translates the voltage drop to a resistance value.

The resistance measurement requires the generation of a constant-current source that is independent of changes in V_{CC} , using the 2V, ground-referred reference voltage. The circuit of *Figure 3* accomplishes this.

In *Figure 3*, A1 establishes a constant-current sink by forcing node A to V_{REF} , the voltage level at A1's non-inverting input. With node A held constant at V_{REF} (2.000V), current through R2 is also fixed—since Q1's collector current is determined by the αI_E product—thus establishing V1 as

$$V1 = V_{CC} - \alpha(V_{REF}/R1)R2 \quad (1)$$

Note that V_{REF} is derived from the LM336—a precision voltage source. Equation (1) shows, then, that (all else remaining constant) V1 varies directly with changes in V_{CC} ; i.e., V1 tracks V_{CC} . The A1/Q1 pair thus establishes a voltage across R2 that floats, independent of changes in the ground-referenced potentials (V_{CC} and V_{REF}) that define it.

Now look at the A2/Q2 circuitry. The closed-loop operation of A2 tries to maintain a zero differential voltage between its input terminals. A2's non-inverting input is held at V1; thus, A2's inverting input is driven to V1. The current through R_L (Q2's emitter current) is therefore $(V_{CC} - V1)/R_L$. Since V1 tracks V_{CC} , then $(V_{CC} - V1)$ —the voltage drop across R_L —is constant, thus producing I_{SOURCE} (*Figure 3*)—the constant source current needed for the resistance measurement.

Note, that varying R_X will not affect I_{SOURCE} so long as the voltage drop across R_X is less than $(V1 - V_{BE2})$. Should V_{RX} exceed $(V1 - V_{BE2})$, Q2 would saturate, invalidating the measurement. The ADD3501 eliminates this worry, however, because as soon as the drop across R_X equals or exceeds the 2V full-scale input voltage the ADD3501 will display an OFL condition.

Finally, SW1 (*Figure 3*) is required as part of the VOLTS/AMPS/OHMS mode selection circuitry; in the VOLTS/AMPS position it prevents Q2's base-emitter junction pulling the V- supply to ground through A2.

TABLE I. DMM PERFORMANCE

Measurement Mode	Range					Frequency Response	Accuracy	Overrange Display
	0.2	2	2	200	2000			
DC Volts	—	V	V	V	V	—	≤ 1% F.S.	± OFLO
AC Volts	—	V_{RMS}	V_{RMS}	V_{RMS}	V_{RMS}	40 Hz to 5 kHz	≤ 1% F.S.	+ OFLO
DC Amps	mA	mA	mA	mA	mA	—	≤ 1% F.S.	± OFLO
AC Amps	mA_{RMS}	mA_{RMS}	mA_{RMS}	mA_{RMS}	mA_{RMS}	40 Hz to 5 kHz	≤ 1% F.S.	+ OFLO
Ohms	$k\Omega$	$k\Omega$	$k\Omega$	$k\Omega$	$k\Omega$	—	≤ 1% F.S.	+ OFLO

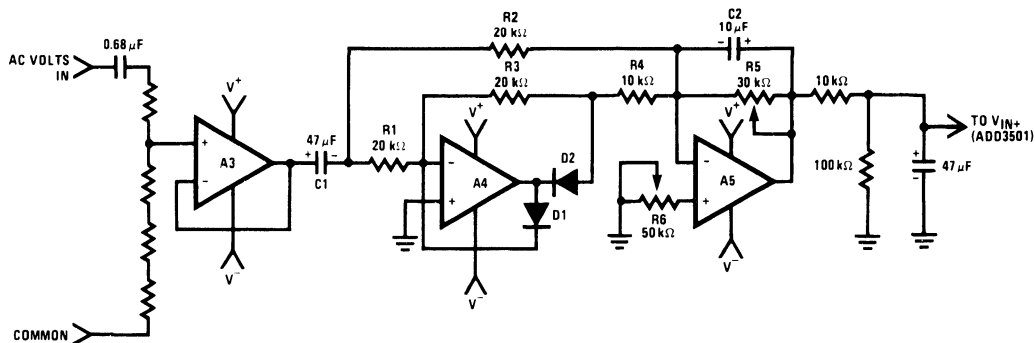


FIGURE 2. AC/DC Converter

TL/H/5617-2

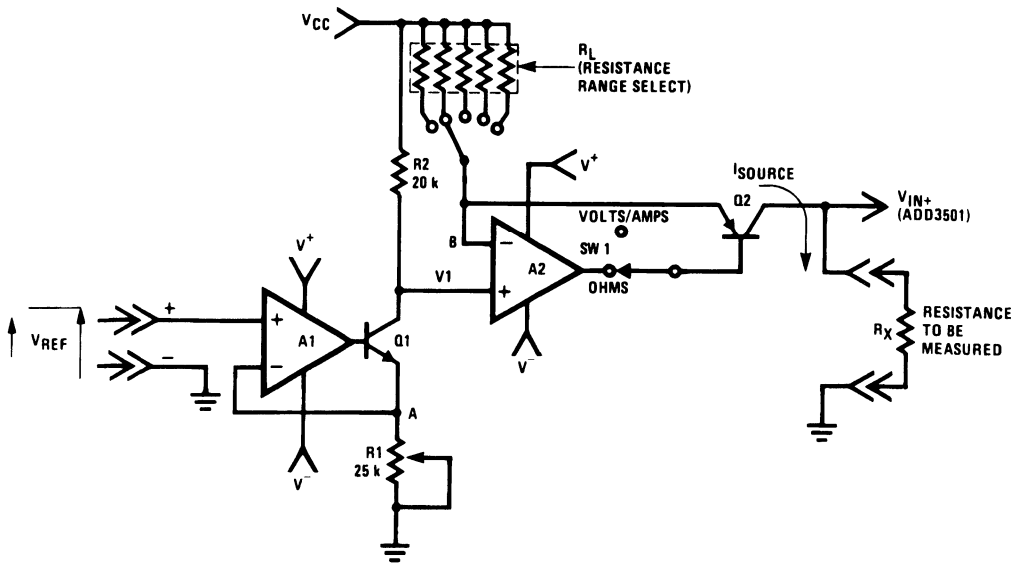


FIGURE 3. Constant-Current Source

TL/H/5617-3

CALIBRATION

Calibrate the DMM according to the following sequence of operations:

- Adjust P1 until the cathode voltage of the reference diode, LM336, equals 2.49V. This reduces the diode's temperature coefficient to its minimum value.
 - Short the (+) and (-) probe inputs of the ADD3501 and adjust P2 until the display reads 0000.
 - Apply 1.995 volts across the (+) and (-) probe inputs and adjust P3 until the display reads 1.995.
 - Select a precision resistor with a value near full-scale or the 2 MΩ range, and adjust P4 until the appropriate value is displayed.
 - Apply a known 1.995V_{rms} sinewave signal to the DMM and adjust P5 until the display reads the same.
- DC Volts 2V Range
- DC Volts 2V Range
- Ohms 2 MΩ Range
- AC Volts 2V Range

PC BOARD LAYOUT

It is imperative to have only one, single-point, analog signal ground connection for the entire system. In a multi-ground layout, the presence of ground-loop resistances will cause the op amps' offset currents and AC response to have a devastating effect on system gain, linearity, and display LSD flicker. Similar precautions must also be taken in the layout of the analog and high-switching-current (digital) paths of the ADD3501.

A FINAL NOTE

The digital multimeter described in this note was developed with the goals of accuracy and low cost. For the high-end DMM market segments, however, improvements to the

basic circuit of *Figure 1* are possible in the following areas:

- Expand the VOLTS mode to include a 200 mV full-scale range;
- Decrease the full-scale current-measurement loading voltage from 2V to 200 mV; and,
- Provide a true-rms measurement capability.
- Increase resolution by substituting the ADD3701—3 3/4-digit DVM chip—which is interchangeable and provides a maximum display count of 3.999.

The first 2 improvements involve a dividing down of the ADD3501 feedback loop by a ratio of 10:1, which reduces the 2V full-scale input requirement to 200 mV. This not only allows a 200 mV signal between the ADD3501's V_{IN+} and V_{IN-} inputs to display a full-scale reading, but implies that the maximum voltage dropped across the current-measuring-mode resistance also will be 200 mV. Note, though, that the values of the current-measurement resistors must be scaled down by a factor of ten.

Additionally, a 200 mV full-scale input implies a resolution of 100 μV/LSD. At such low input levels, the DMM may require some clever circuitry to eliminate the gain and linearity distortions that can arise from the offset currents in the AC-to-DC converter.

The third possible improvement—the reading of true-rms values—can be implemented by replacing the AC-to-DC converter of *Figure 2* with National's LH0091, a true-rms-to-DC converter, and appropriate interface circuitry.

REFERENCES:

- ADD3501 Data Sheet.
- LH0091 Data Sheet.
- LM336 Data Sheet.
- Application Note AN-20.
- ADD3701 Data Sheet.

New Phase-Locked-Loops Have Advantages as Frequency to Voltage Converters (and more)

National Semiconductor
Application Note 210
Robert Pease



AN-210

A phase-locked-loop (PLL) is a servo system, or, in other words, a feedback loop that operates with frequencies and phases. PLL's are well known to be quite useful (powerful, in fact) in communications systems, where they can pluck tiny signals out of large noises. Here, however, we will discuss a new kind of PLL which cannot work with low-level signals immersed in noise, but has a new set of advantages, instead. It does require a clean noise-free input frequency such as a square wave or pulse train.

This PLL can operate over a wide frequency range, not just 1 or 2 octaves but over 1 or 2 or 3 decades. It naturally provides a voltage output which responds quickly to frequency changes, yet does not have any inherent ripple. Thus, it can be used as a frequency-to-voltage (F-to-V)

converter which does not have any of the classical limitations or compromises of (large ripple) vs (slow response), which most F-to-V converters have.¹ The linearity of this F-to-V converter will be as good as the linearity of the V-to-F converter used, and this linearity can easily be better than 0.01%. Other advantages will be apparent as we study the circuit further.

The basic circuit shown in *Figure 1* has all the functional blocks of a standard PLL. The frequency and phase detection do not consist of a quadrature detector, but of a standard dual-D flip-flop. When the frequency input is larger than F_2 , Q1 will be forced high a majority of the time, and provide a positive error signal (via CR3, 4, 5, and 6) to the integrator.

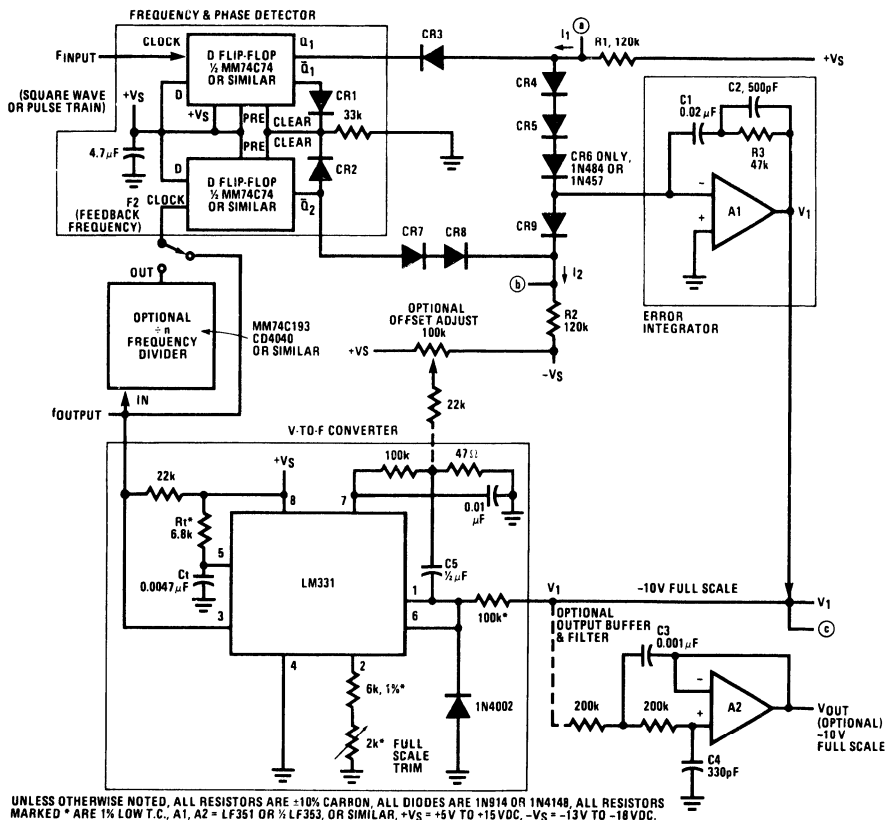


FIGURE 1. Basic Wide-Range Phase-Locked Loop

1. AN-207, V-to-F and F-to-V Converter Applications.

TL/H/5618-1

If F input and F_2 are the same, but the rising edges of F input lead the rising edges of F_2 , the duty cycle of $Q1=HI$ will be proportional to the phase error. Thus, the error signal fed to the integrator will decrease to nearly zero, when the loop has achieved phase-lock, and the phase error between F_{IN} and F_2 is zero. Actually, in this condition, $Q1$ will put out 30 nanosecond positive pulses, at the same time that $Q2$ puts out 30 nanosecond negative pulses, and the net effect as seen by the integrator is zero net charge. The 30 nanosecond pulses at $Q1$ and $Q2$ enable both flip-flops to be CLEARED, and prepared for the next cycle. This phase-detector action is substantially the same as that of an MC4044 Phase-Detector, but the MM74C74 is cheaper and uses less power. It is fast enough for frequencies below 1 MHz. (At higher frequencies, a DM74S74 can be used similarly, with very low delays.)

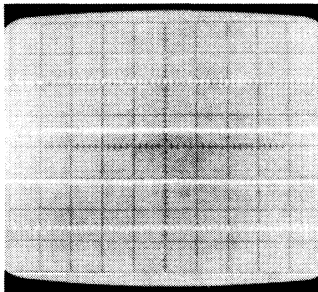
The error integrator takes in the current from $R1$ or $R2$, as gated by the $Q1$ and $Q2$ outputs of the flip-flop. For example, when F_{IN} is higher, and $Q1$ is HIGH, I_1 will flow through $CR4$, 5, and 6 and cause the integrator's output to go more negative. This is the direction to make the V-to-F converter run faster, and bring F_2 up to F input. Note that $A1$ does not merely integrate this current in $C1$ (a mistake which many amateur PLL designers make!). The resistor $R3$ in series with $C1$ makes a phase *lead* in the loop response, which is essential to loop stability. The small capacitor $C2$ across $R3$ is not essential, but has been observed to offer improved settling at the voltage output.

The output of the integrator, $V1$, is fed to a voltage-to-frequency (V-to-F) converter. The example shown here utilizes a LM331. This converter runs on a single supply, and responds quickly with nonlinearity better than 0.05% (even though an op-amp is not used nor needed). The output of the VFC is fed back to F_2 , as a feedback frequency, either directly or through an (optional) frequency divider. Any number of standard frequency dividers such as MM74C193, CD4029, or CD4018, can be used, subject to reasonable limits. A divider of 2, 3, 10, or 16 is often used. The output voltage of the integrator will be proportional to the F input, as linearly as the V-to-F can make it. Thus, the integrator's

output voltage $V1$ can be used as the output of an ultralinear F-to-V converter. However during the brief pulses when the flip-flop is CLEARing itself, there will be small glitches found on the output of $A1$. The RMS value of this noise may be very small, typically 0.5 to 5mV, but the peak amplitude, sometimes 10 to 100mV, can be annoying in some systems. And, no additional filtering can be added in the main loop's path, for any further delay in the route to the VFC would cause loop instability. Instead, the output may be obtained from a separate filter and buffer which operates on a branch path. $A2$ provides a simple 2-pole active filter (as discussed in Reference 1) which cuts the steady-state ripple and noise down below 1mV peak-to-peak an excellent level for such a quick F-to-V (as we shall see).

What is not obvious about $A2$ is that its output can settle (within a specified error-band such as ± 10 millivolts from the final DC value) earlier and more quickly than $A1$'s output. The waveforms in *Figure 2* show F_{IN} stepping up instantly from 5 kHz to 10 kHz; it also shows F_2 stepping up very quickly. The error signal at $Q1$ is also shown. The critical waveforms are shown in *Figure 3*, the outputs of $A1$ and $A2$. While $A1$ puts out large spikes (caused by $I1$ flowing through $R3$), these large spikes cause the V-to-F converter to jump from 5 kHz to 10 kHz without any delay. There is, as shown in *Figure 2*, a significant phase error between F_{IN} and F_2 , but an inspection of these frequencies shows that frequency lock has been substantially instantaneous. Not one cycle has been lost! The phase lock and settling takes longer to achieve. Still, we know that if the frequency out of the VFC is 10 kHz, its input voltage must be -10 VDC. If there is noise on it, all we have to do is filter it in $A2$. *Figure 3* shows that $A2$ settles very quickly — actually, in 2.0 milliseconds, which is just 20 cycles of the new frequency. $A2$'s output has settled (i.e., the frequency has settled), while $A1$'s output error (which is indicative of phase error being servo'ed out) continues to settle out for another 12 ms. Thus, this filter permits its output voltage to settle faster than its input, and it is responsible for the remarkable quickness of this circuit as an F-to-V converter. The waveforms of

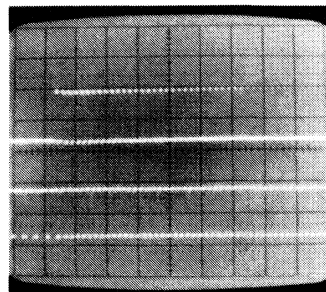
Vertical sensitivity = 10 V/DIV (CMOS logic levels)
Horizontal sensitivity = 0.5 ms/DIV



TL/H/5618-2

FIGURE 2a. F output steps up from 5 kHz to 10 kHz as quickly as the input, never missing a beat.
Top Trace = input " F_{IN} " to PLL.
Bottom Trace = output " F_{OUT} " from PLL.

Vert = 10 V/DIV, Horiz = 0.5 ms/DIV

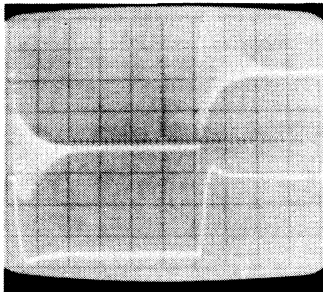


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FIGURE 2b. Error Signal. Top Trace = error signal at $Q1$. Bottom Trace = output " F_{OUT} " from PLL.

Figure 3 can be compared to the response (shown in Figure 4) of a conventional F-to-V converter. The upper trace is the output of a conventional FVC after a 4-pole filter²,

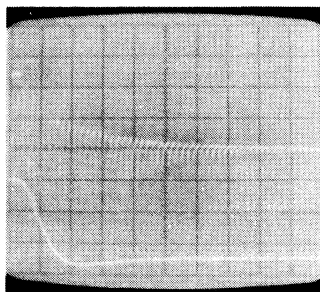
Vert = 2 V/DIV, Horiz = 2 ms/DIV



TL/H/5618-4

FIGURE 3a. Settling waveforms, as F_{IN} goes from 5 kHz to 10 kHz and back again, using circuit of Figure 1. Top Trace = output of integrator (V_1). Bottom Trace = output of filter (V_{OUT}).

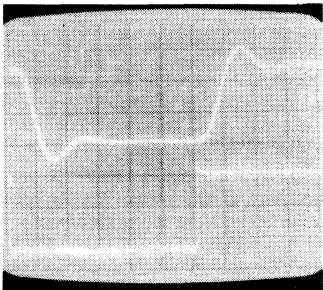
Vert = 2 V/DIV, Horiz = 0.5 ms/DIV



TL/H/5618-5

FIGURE 3b. PLL Settling Waveforms. The same waveform as in Figure 3a, but time base is expanded to 0.5 ms/DIV to show fine detail of settling.

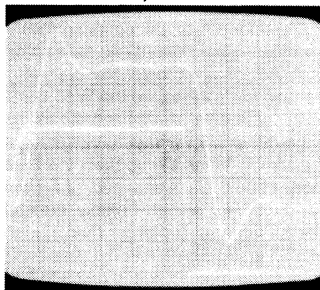
Vert = 2 V/DIV, Horiz = 20 ms/DIV



TL/H/5618-6

FIGURE 4a. FVC Response vs PLL Response. The PLL can settle rather more quickly than a conventional F-to-V converter. Top Trace = conventional F-to-V converter with 4-pole active filter, responding to a 5 kHz to 10 kHz step. Bottom Trace = PLL FVC, with the same input, circuit of Figure 1.

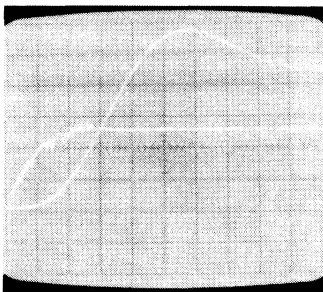
Vert = 2 V/DIV, Horiz = 20 ms/DIV



TL/H/5618-7

FIGURE 4b. FVC Step Response. This waveform is similar to that in Figure 4a but the frequency change covers a 10:1 ratio, from 10 kHz to 1 kHz and back to 10 kHz. For this waveform, the adaptive current sources of Figure 5 connect to Figure 1 (whereas for Figure 4a $R_1 = R_2 = 120k$).

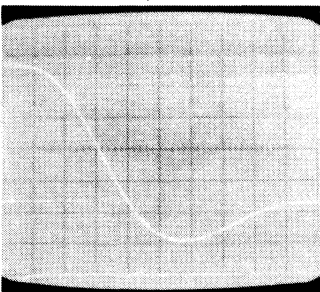
Vert = 2 V/DIV, Horiz = 5 ms/DIV



TL/H/5618-8

FIGURE 4c. FVC Response. The same as Figure 4b, but time base expanded to 5 ms/DIV, to show detail of rise time. Top Trace = conventional FVC. Bottom Trace = PLL FVC.

Vert = 2 V/DIV, Horiz = 5 ms/DIV

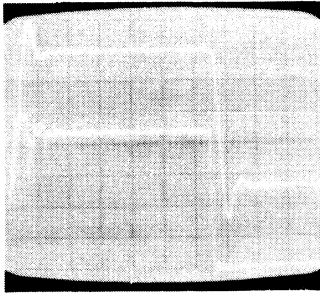


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FIGURE 4d. FVC Response The same as Figure 4b, but expanded to 5 ms/DIV to show details of fall time. Top Trace = conventional FVC. Bottom Trace = PLL FVC.

and the lower trace is the output of the circuit of Figure 1. The phase-locked-loop F-to-V converter is quicker yet quieter.
2. AN-207, V-to-F and F-to-V Converter Applications.

Vert = 0.2 V/DIV, Horiz = 50 ms/DIV



TL/H/5618-10

FIGURE 4e. PLL Settling Waveforms at Low Frequencies. The same idea as in *Figure 4b*, but $10 \times$ slower, from 1.0 kHz to 100 Hz (and back). The settling to 1 kHz is still distinctly faster for the PLL, but at 100 Hz, it is a bit slower. Still, the PLL is faster than the FVC at all speeds from 200 Hz to 10 kHz.

So far we have shown a PLL which operates nicely over a frequency range of about 3:1. If the frequency is decreased below 3 kHz, the loop gain becomes excessive, and the currents I1 and I2 are large enough to cause loop instability. The loop gain increases at lower frequencies, because a given initial phase error will cause the fixed current from R1 or R2 to be integrated for a *longer* time, causing a *larger* output change at the integrator's output, and a *larger* change of frequency. When the frequency is thus corrected, and the period of one cycle is changed, at a low frequency it may be *over-corrected*, and the phase error on the next cycle may be as large as (or larger than) the initial phase error, but with reversed sign.³ To avoid this and to maintain loop stability at lower frequencies, e.g. 0.5 to 1 kHz, R1 and R2 can be simply raised to 1.5 M Ω . However, response to a step will be proportionally slower. To achieve a wide frequency range (20:1), and optimum quickness at all frequencies, it is necessary to servo I1 and I2 to be *proportional to the frequency*. Fortunately, as V1 is normally proportional

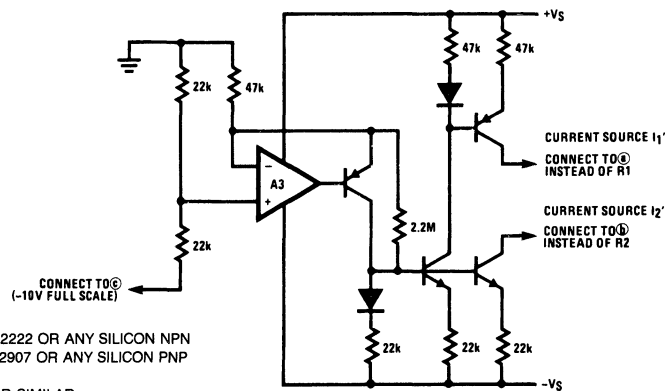
to F, it is easy to generate current sources I1' and I2' which are proportional to F. The circuit of *Figure 5* can be connected to the basic PLL, instead of R1 and R2, and provides good, quick loop stability over a 30:1 frequency range, from 330 Hz to 10 kHz. For best results over a 30:1 frequency range, change R3, the damping resistor in *Figure 1*, from 47k to 100k. However, if the frequency range is smaller (such as 2:1 or 3:1), constant resistors for R1 and R2 or very simple current sources may give adequate response in many systems. (To cover wider frequency ranges than 30:1 with optimum response, the circuits in the precision phase-locked-loop, below, are much more suitable.)

Often a frequency multiplier is needed, to provide an output frequency 2 or 3 or 10 or n times higher than the input. By inserting a $\div n$ frequency divider in the feedback loop, this is easily accomplished. [Of course, a $\div m$ frequency divider can be inserted ahead of the frequency input, to provide correct scaling, and the output frequency then will be $F_{IN}(n/m)$.]

To obtain good loop stability in a frequency multiplier with $n = 2$, remember that a 20 kHz V-to-F converter followed by a $\div 2$ circuit has exactly the same loop response and stability needs as a 10 kHz V-to-F converter, because it *is* a 10 kHz V-to-F converter, even though it provides a useful 20 kHz output. Thus, the frequency of the F_2 (minimum and maximum) will determine what loop gains and loop damping components are needed.

To accommodate a 1 kHz V-to-F loop, simply make C1 and C2 10 times bigger than the values of *Figure 1*; treat C3, C4, C5 and Ct similarly is used. To accommodate a 100 Hz V-to-F, increase them by another factor of 10.

If the PLL is to be used primarily as a frequency multiplier, it may be necessary to use stable, low-temperature-coefficient components, because the accuracy of V_{OUT} will not be important. The parts cost can be cut considerably. (Make sure that the VFC does not run out of range to handle all frequencies of interest.) On the other hand, the damping components will be chosen quite a bit differently if slow, stable jitter-free response is needed or if quick response is required. The circuits shown are just a starting place, to start optimizing your own circuit.



A3 — LF351, LM741 OR ANY
NPN TRANSISTOR — 2N3904, 2N2222 OR ANY SILICON NPN
PNP TRANSISTOR — 2N3906, 2N2907 OR ANY SILICON PNP
ALL RESISTORS $\pm 10\%$
ALL DIODES 1N914 OR 1N4148 OR SIMILAR

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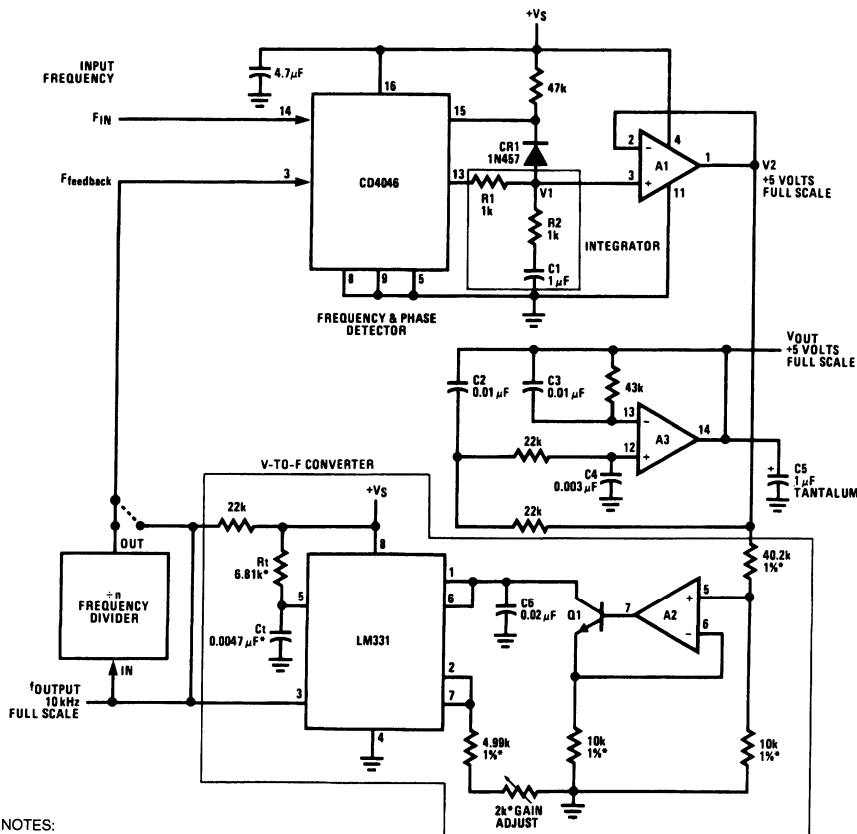
FIGURE 5. Proportional Current Source for Basic PLL

3. Optimize phase-locked loops to meet your needs or determine why you can't. Andrzej B. Przedpelski, *Electronic Design*, September 13, 1978.

A Single-Supply PLL

The single-supply PLL is shown in *Figure 6* as an example of a simple circuit which is effective when battery operation or single-supply operation is necessary. This circuit will function accurately over a 10:1 frequency range from 1 kHz to 10 kHz, but will not respond as quickly as the basic PLL of *Figure 1*. The reason is the use of the CD4046 frequency detector. When an F_{IN} edge occurs ahead of a F feedback pulse, pin 13 of the CD4046 pulls up on C_1 via $R_1 = 1\text{ k}\Omega$. This current cannot be controlled or manipulated over as wide a range as "I1" in *Figure 1*. As a consequence, the response of this PLL is never as smooth nor fast-settling as the basic PLL, but it is still better behaved than most F-to-V converters. As with the basic PLL, the detector feeds a cur-

rent to be integrated in C_1 (and R_2 provides the necessary "lead"). A_1 acts simply as a buffer for the R_1, C_1 integrator. A_3 , optional, can provide a nicely filtered output. And A_2 serves Q_1 , drawing a current out of C_6 which is proportional to V_2 . Here the LM331 acts as a current-to-frequency converter, and F output is precisely proportional to the collector current of Q_1 . As with the basic circuit, this PLL can be used as a quick and/or quiet F-to-V converter, or as a frequency multiplier. One of the most important uses of an F-to-V is to demodulate the frequency of a V-to-F converter, which may be situated at a high common-mode voltage, isolated by photoisolators, or to recover a telemetered signal. An F-to-V converter of this sort can provide good bandwidth for demodulating such a signal.



- NOTES:
- $Q_1 = 2N3565$ OR $2N3904$ HIGH BETA NPN
 - $A_1, A_2, A_3 = \frac{1}{4}$ LM324
 - ON CD4046, PINS 1, 2, 4, 6, 7, 10, 11, 12 ARE NO CONNECTION
 - USE STABLE, LOW-T.C. PARTS FOR COMPONENTS MARKED*
 - $+V_S = +7$ TO $+15$ VDC

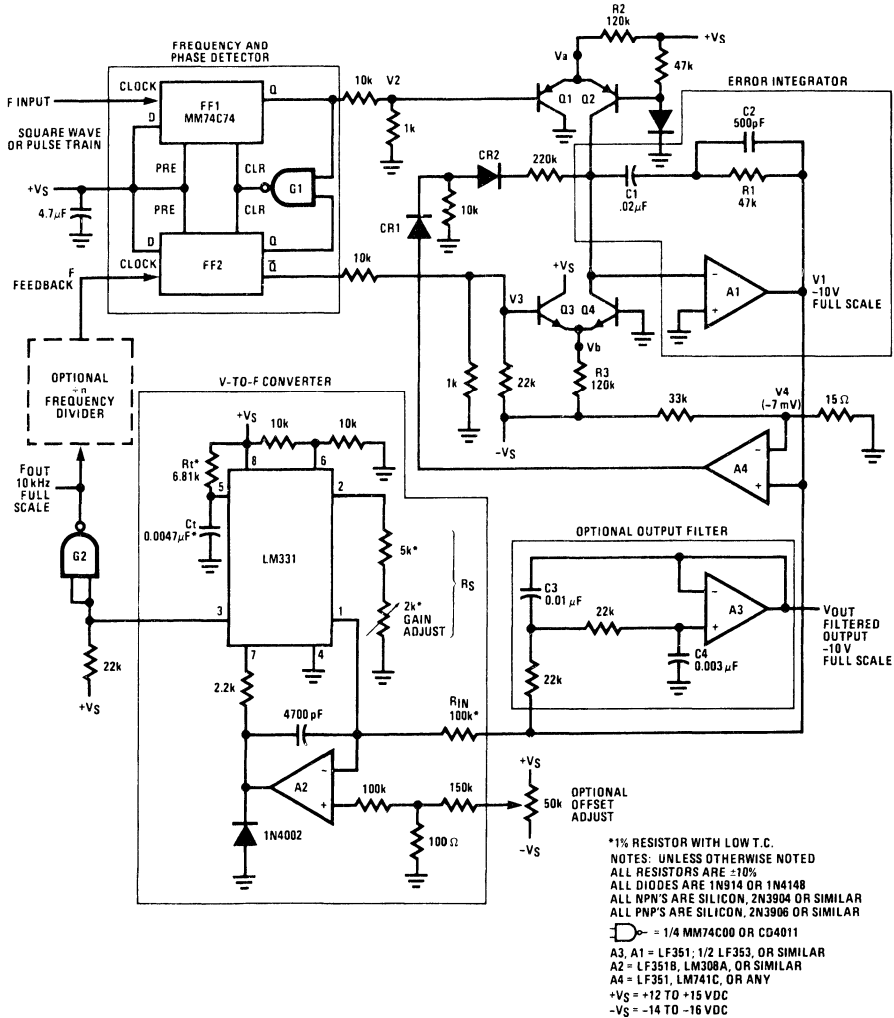
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FIGURE 6. Single Supply Phase Locked Loop

The precision PLL in *Figure 7* acts very much the same as the basic PLL, with refinements in various places.

- The flip-flops in the detector have a gate G1 to CLEAR them, for quicker response.
- The currents which A1 integrates are steered through Q1, Q2 and Q3, Q4 because transistors are quicker than diodes, yet have much lower leakage.

- The V-to-F converter uses A2 as an op-amp integrator, to get better than 0.01% nonlinearity (max).
- G2 is recommended as an inverter, to invert the signal on the LM331's pin 3, avoid a delay, and improve loop stability. (However, we never found any *real* improvement in loop stability, despite theories that insist it must be there. Comments are invited.)



TL/H/5618-13

- A4 is included as an (optional) limiter, to prevent V1 from ever going positive. This will facilitate quick startup and recovery from overdrive conditions.

Also, in *Figure 8*, the wide-range current pump for the precision PLL is a "semiprecision" circuit, and provides an output current proportional to $-V_1$, give or take 10 or 15%, over a 3-decade range. The 22 M Ω resistors prevent the current from shutting off in case $-V$ becomes positive (probably unnecessary if A4 is used). For best results over a full 3-decade range (11 kHz to 9 Hz), do use A4, delete the four 22 M Ω resistors, and insert the (diode parallel to the 470 k Ω) in series with the R_G as shown. This will give good stability at all frequencies (although stability cannot be extended below 1/1500 of full scale without extra efforts).

This PLL has been widely used in testing of VFCs, as it can force the LM331 to run at a crystal-controlled frequency (established as the F input), and the output voltage at V_{OUT} is promptly measured by a 6-digit (1 ppm nonlinearity, max) digital voltmeter, with much greater speed and precision than can be obtained by forcing a voltage and trying to read a frequency. While at 10 kHz, the advantages are clearcut; at 50 Hz it is even more obvious. Measuring a 50 Hz signal with ± 0.01 Hz resolution cannot be done (even with the most powerful computing counter-timer) as accurately, quickly, and conveniently as the PLL's voltage output settles.

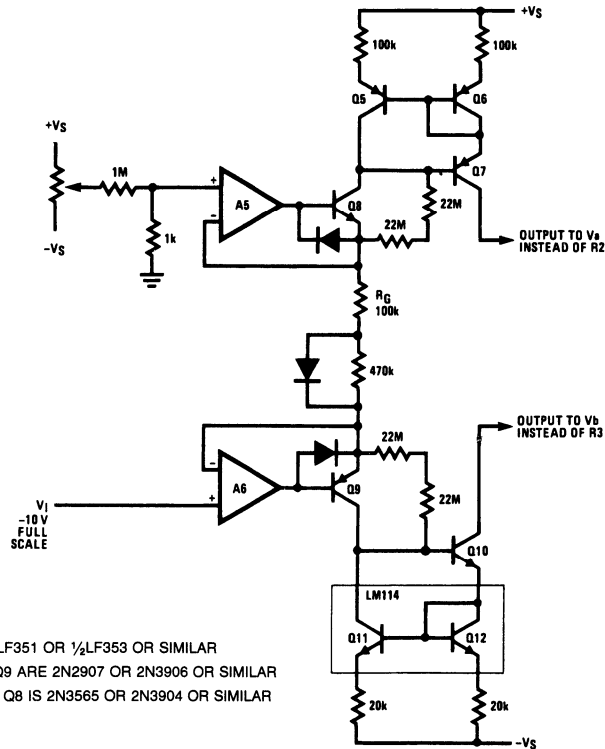


FIGURE 8. Wide Range Current Pumps for Precision PLL of *Figure 7*

TL/H/5618-14

One final application of this PLL is as a wide-range sine generator. The VFC in Figure 9 puts out an adequate sine-shaped output, but does not have good V-to-F linearity, and its frequency stability is not much better than 0.2%. An LM331 makes an excellent linear stable V-to-F converter, with a pulse output; but it can not make sines. But it can command, via a PLL, to force the sine VFC of Figure 9

into one of the PLLs, instead of the LM331 VFC circuit. Then use a precise linear low-drift VFC based on the LM331 to establish the F_{IN} to the PLL. If the voltage needed by the sine VFC to put out a given frequency drifts a little, that is okay, as the integrator will servo and make up the error. The use of a controlled sine-wave generator in a test system was the first of many applications for a wide-range phase-locked-loop.

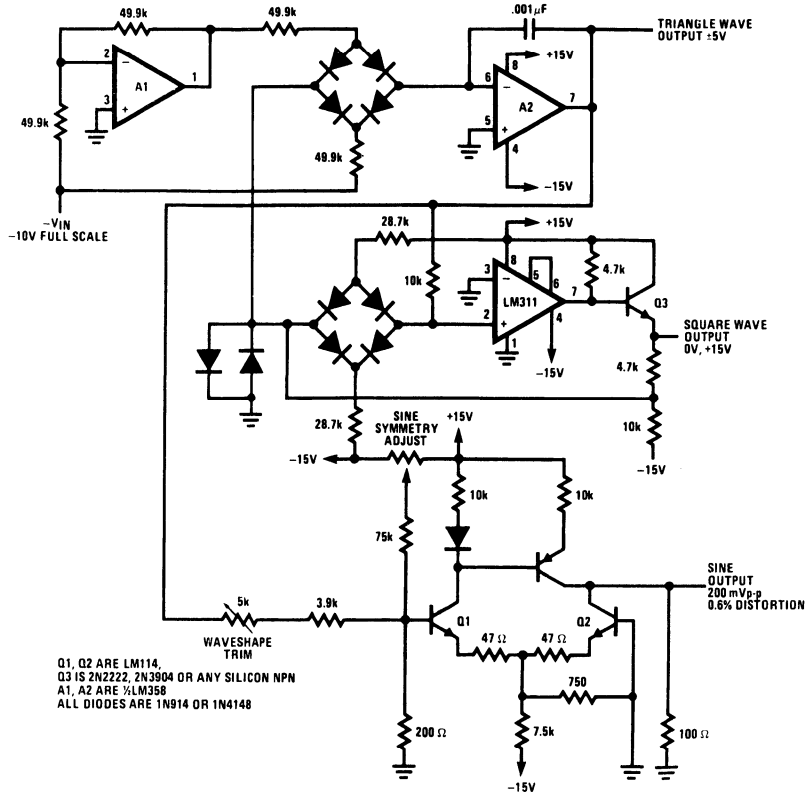


FIGURE 9. Sine-Wave VFC to Use with PLL

TL/H/5618-15

New Op Amp Ideas

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Mexico

National Semiconductor
Application Note 211
Mineo Yamatake



Abstract: An op amp and voltage reference capable of single supply operation down to 1.1V is introduced. Performance is uncompromised and compares favorably with standard, state-of-the-art devices. In a departure from conventional approaches, the circuit can operate in a floating mode, powered by residual voltages, independent of fixed supplies. A brief description of the IC design is given, but emphasis is on applications. Examples are given for a variety of remote comparators and two-wire transmitters for analog signals. Regulator designs with outputs ranging from a fraction of a volt to several hundred volts are discussed. In general, greater precision is possible than with existing ICs. Designs for portable instruments are also looked into. These applications serve to emphasize the flexibility of the new part and can only be considered a starting point for new designs.

introduction

Integrated circuit operational amplifiers have reached a certain maturity in that there no longer seems to be a pressing demand for better performance. Devices are available at low cost for all but the most exacting needs. Of course, there is always room for improvement, but even substantial changes in specifications cannot be expected to cause much excitement.

A new approach to op amp design and application has been taken here. First, the amplifier has been equipped to function in a floating mode, independent of fixed supplies. This, however, in no way restricts conventional operation. Second, it has been combined with a voltage reference, since these two functions are often interlocked in equipment design. Third, the minimum operating voltage has been reduced to nearly one volt. It will be seen that these features open broad new areas of application.

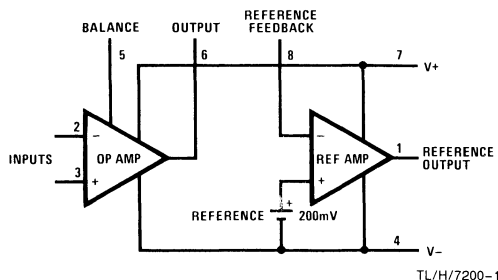


Figure 1. Functional diagram of the new IC

A functional diagram of the new device is shown in Figure 1. Even though a voltage reference and a reference amplifier have been added, it can still be supplied in an eight-pin TO-5 or mini-DIP. The pin connections for the op amp are the same as the industry standards. And offset balancing that tends to minimize drift has been provided. Both the op amp and the reference amplifier are internally compensated for unity-gain feedback.

Table I shows that, except for bias current, the general specifications are much as good as the popular LM108. But the new circuit has a common mode range that includes V^- and the output swings within 50 mV of the supplies with 50 μ A load, or within 0.4V with 20 mA load. These parameters are specified in Table I as the conditions under which gain and common-mode rejection are measured. Table II indicates that the reference compares favorably with the better ICs on the market today.

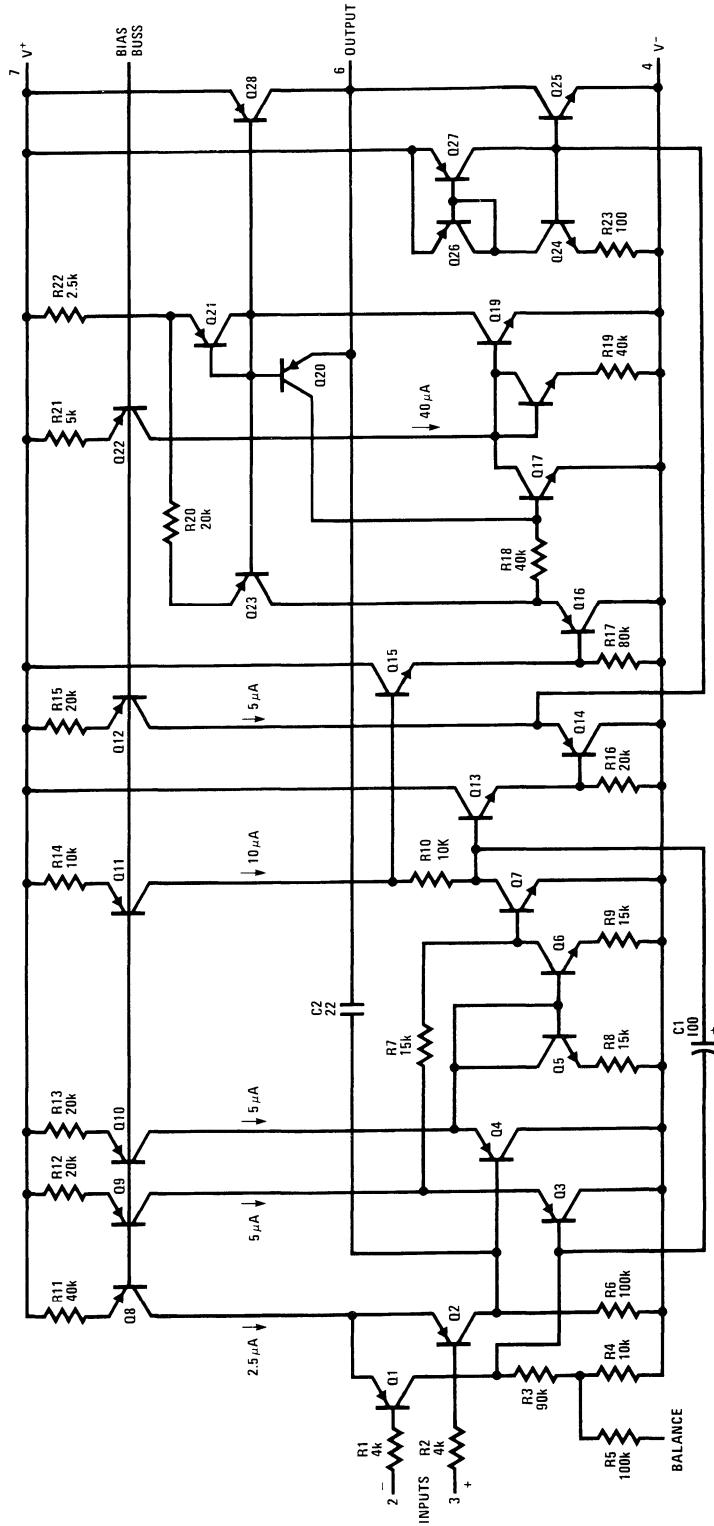
TABLE I. Typical Performance of the Operational Amplifier at 25°C

Parameter	Conditions	Value
Input Offset Voltage		0.3 mV
Offset Voltage Drift	$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$	$2 \mu\text{V}/^\circ\text{C}$
Input Offset Current		0.25 nA
Offset Current Drift	$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$	$2 \text{ pA}/^\circ\text{C}$
Input Bias Current		10 nA
Bias Current Drift	$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$	$40 \text{ pA}/^\circ\text{C}$
Common-Mode Rejection	$V^- \leq V_{\text{CM}} \leq V^+ - .85\text{V}$	102 dB
Supply-Voltage Rejection	$1.2\text{V} \leq V_S \leq 40\text{V}$	96 dB
Unloaded Voltage Gain	$V_S = \pm 20\text{V}$, $V_O = \pm 19.95\text{V}$, $I_O \leq 50 \mu\text{A}$	$400\text{V}/\text{mV}$
Loaded Voltage Gain	$V_S = \pm 20\text{V}$, $V_O = \pm 19.6\text{V}$, $R_L = 980\Omega$	$130\text{V}/\text{mV}$
Unity-Gain Bandwidth	$1.2\text{V} \leq V_S \leq 40\text{V}$	0.3 MHz
Slew Rate	$1.2\text{V} \leq V_S \leq 40\text{V}$	$0.15\text{V}/\mu\text{s}$

TABLE II. Typical Performance of the Reference at 25°C

Parameter	Conditions	Value
Line Regulation	$1.2\text{V} \leq V_S \leq 40\text{V}$	$0.001\%/V$
Load Regulation	$0 \leq I_O \leq 1 \text{ mA}$	0.01%
Feedback Sense Voltage		200 mV
Temperature Drift	$-55^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$	$0.002\%/^\circ\text{C}$
Feedback Bias Current		20 nA
Amplifier Gain	$0.2\text{V} \leq V_O \leq 35\text{V}$	$75\text{V}/\text{mV}$
Total Supply Current	$12\text{V} \leq V_S \leq 40\text{V}$	270 μ A

Since worst-case internal dissipation can easily exceed 1W under overload conditions, thermal overload protection is included. Thus at higher ambient temperatures, this circuit is better protected than conventional op amps with lesser output capabilities.



TL/H/7200-2

Figure 2. Essential details of the op amp

Figures 2 and 5 are simplified schematics of the op amp, the reference and the internal current regulator. A complete circuit description is a subject in itself and is covered in detail elsewhere [1]. However, a brief run through the circuit is in order to give some understanding of the details that affect application.

the op amp

Referring to Figure 2, lateral PNPs are used for the op amp input because this was the only reasonable way to get V^- included in the common-mode range while meeting the minimum-voltage requirement. These transistors typically have $h_{FE} > 100$ at $I_C = 1 \mu A$ and appear to match better than their NPN counterparts. Current gain is less affected by temperature, resulting in a fairly flat bias current over temperature (Figure 3). At elevated temperature the sharp decrease in bias current for $V_{CM} > V^-$ is caused by the same substrate leakage that affects bi-FET op amps.

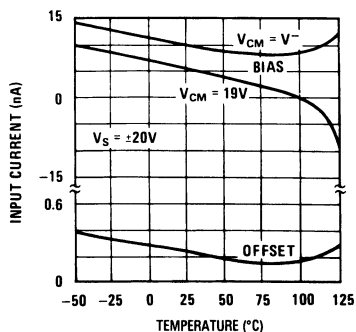
Protective resistors have been included in the input leads so that current does not become excessive when the inputs are forced below the negative supply, forward biasing the base tubs of the lateral PNPs.

Offset nulling is accomplished by connecting the balance terminal to a variable voltage derived from the reference output, as shown in Figure 4. Both the input stage collector voltage and the reference are well regulated and have a low temperature drift. The resistance of the adjustment potentiometer can be made very much lower than the resistance looking back into the balance pin. Therefore, no matching of temperature coefficients is required and offset nulling will tend to produce a minimum-drift condition.

With 200 mV on the balance control, the balance range is asymmetrical. Standard parts are trimmed to bring them into the -1 mV to 8 mV adjustment range. Null sensitivity can be reduced for low-offset premium parts by adding a resistor on the top end of R1.

Proceeding through the circuit, the input stage is buffered by vertical PNP followers, Q3 and Q4. From here, the differential signal is converted to single ended and fed to the base of the second stage amplifier, Q7.

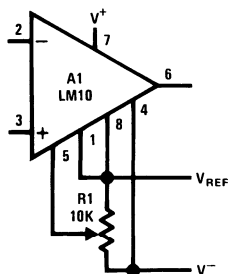
This configuration is not inherently balanced in that the emitter-base voltage of the PNP transistors is required to match that of the NPNs. The final design includes circuitry to correct for the expected variations.



TL/H/7200-3

Figure 3. Variation of input current with temperature

From the collector of Q7, the signal splits, driving separate halves of the complementary class-B output stage. The NPN output transistor, Q25, is driven through Q13 and Q14.



TL/H/7200-4

Figure 4. Op amp offset adjustment

This complementary emitter follower arrangement provides the necessary current gain without requiring the extra bias voltage of the Darlington connection.

Base drive for the NPN output transistor is initially supplied by Q12, but a boost circuit has also been added to increase the available drive as a function of load current. This is accomplished by Q24 in conjunction with a current inverter.

Drive for the PNP half of the output is somewhat more complicated. Again, a compound buffer, Q15 and Q16, is used, although to maintain circuit balance rather than for current gain. The signal proceeds through two inverters, Q17 and Q19, to obtain the correct phase relationship and DC level shift before it is fed to the PNP output transistor, Q28.

This path has three common-emitter stages and, potentially, much higher gain than the NPN side. The gain is equalized, however, by the shunting action of Q18-R19 and Q21-R22 as well as negative feedback through Q23.

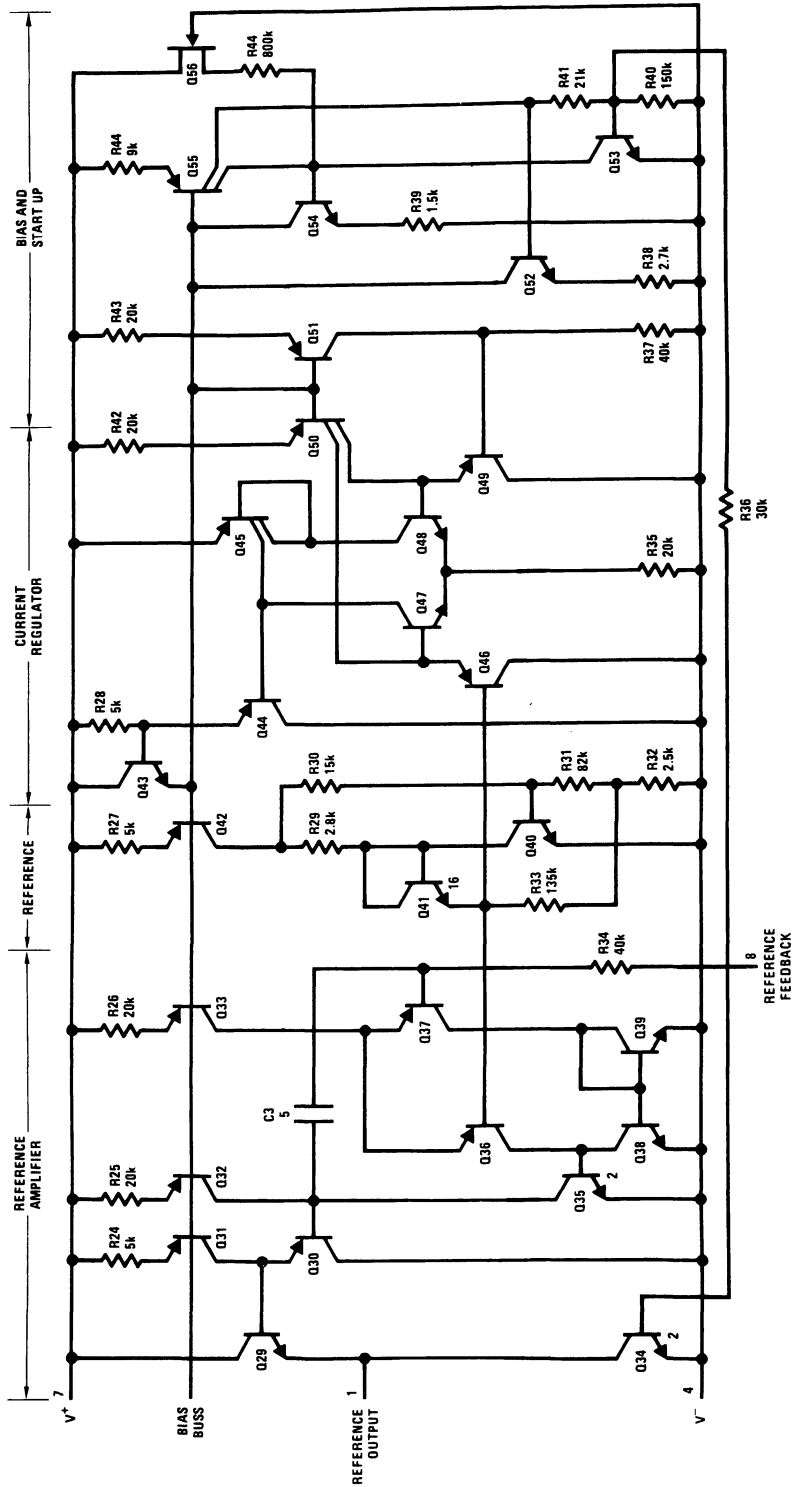
When the output PNP saturates, Q20 serves to limit its base overdrive with a feedback path to the base of Q17. As will be seen, Q20 is also important to floating-mode operation in that it disables the PNP drive circuitry when the op-amp output is shorted to V^+ .

the reference

A simplified version of the reference circuitry and internal current regulator is shown in Figure 5. The design of the band-gap reference is unconventional both in its configuration and because it compensates for the second-order nonlinearities in the emitter-base voltage as well as those introduced by resistor drift. Thus, the bowed characteristic of conventional designs is eliminated, with better temperature stability resulting.

The reference element itself is formed by Q40 and Q41, with the output on the emitter of Q41. The V_{BE} component of the output is developed across R30, while the ΔV_{BE} component is obtained by operating Q41 at a much lower current density than Q40. The output is made less sensitive to variations in biasing current by the action of R29. Curvature correction results from the different temperature coefficients of bias current for the two transistors.

The 200 mV reference voltage is fed to both the reference amplifier and the internal current regulator. The reference amplifier design is straight-forward, consisting of two stages with an emitter follower output. Unlike the op amp, the output can only swing within 0.8V of the positive supply. This should be kept in mind when designing low-voltage circuitry.



TL/H/7200-5

Figure 5. Simplified schematic of the reference and internal current regulator

A minimal sink current ($\sim 20 \mu\text{A}$) is supplied by Q34. And since the reference is not included in the thermal protection control loop, conventional current limit is included on the final circuit to limit maximum output current to about 3 mA.

The current regulator is also relatively uncomplicated. A control loop drives the current source bias bus so that the output of one current source (Q51) is proportional to the reference voltage. The remaining current sources are slaved into regulation by virtue of matching.

The remaining circuitry generates a trickle current for start-up and biases internal circuitry.

An analysis of the complete circuit would serve only to bring into focus a multitude of detail such as second-order DC compensation terms, minor-loop frequency stabilization, clamps, overload protection, etc. Although necessary, these particulars tend to obscure the principles being put forward. So, having gained some insight into circuit operation, it is appropriate to proceed to some of the novel applications made possible with this new IC.

floating comparators

The light-level detector in *Figure 6* illustrates floating-mode operation of the IC. Shorting the op-amp output to V^+ disables the PNP half of the class-B output stage, as mentioned earlier. Thus, with a positive input signal, neither half of the output conducts and the current between the supply terminals is equal to the quiescent supply current. With negative input signals, the NPN portion of the output begins to turn on, reaching the short circuit current for a few hundred microvolts overdrive. This is shown in *Figure 7*.

Figure 7 also shows the terminal characteristics for the case where the output is shorted to V^- so that only the PNP side can be activated. This mode of operation has not been so thoroughly investigated, but it gives a slightly lower ON voltage at moderate currents and the gain is generally higher below 70°C . With ON currents less than about 1 mA, the terminal voltage drops low enough to disrupt the internal regulators and the reference, producing some hysteresis. Further, there is a tendency to oscillate over about a $50 \mu\text{V}$ range of input voltage in the linear region of comparator operation.

The above is not intended to preclude operation with the output connected to V^- , if there is a good reason for doing so. It is meant only to draw attention to the problems that might be encountered.

In *Figure 6*, the internal reference supplies the bias that determines the transition threshold. At crossover, the voltage across the photodiode is equal to the offset voltage of the op amp, so leakage is negligible. The circuit can directly drive such loads as logic circuits or silicon controlled rectifiers. The IC can be located remotely with the sensor, with the output transmitted along a twisted-pair line. Alternatively, a common ground can be used if there is sufficient noise immunity; and the signal can be transmitted on a single line.

It should be remembered that this particular design is fully compensated as a feedback amplifier. As such it is not particularly fast in comparator applications. With low-level signals, delays a few hundred microseconds can be expected;

and once in the linear region, the maximum change of terminal voltage is $0.15/\mu\text{s}$. This is illustrated in the plots of *Figures 8* and *9*. In general, high accuracy cannot be obtained with switch frequencies above 100 Hz.

Hysteresis can be provided as shown in *Figure 6* by feedback to the balance terminal. About 1 mV of hysteresis is obtained for a 5V output swing. However, this disappears near 10 Hz operating frequency because of gain loss.

Figure 10 shows a flame detector that can drive digital circuitry directly. The platinum-rhodium thermocouple gives an 8 mV output at 800°C . This threshold is established by connecting the balance pin to the reference output.

linear operation

The IC can also operate linearly in the floating mode. The simplest examples of this are the shunt voltage regulator in *Figure 11* and the current regulator in *Figure 12*. The voltage regulator is straightforward, but the current regulator is a bit unusual in that the supply current of the IC flows through the sense resistor and does not affect accuracy as long as it is less than the desired output current.

It is also possible to use remote amplifiers with two-wire signal transmission, as was done with the comparators. Remote sensors can be particularly troublesome when low-level analog signals are involved. Transmission problems include induced noise, ground currents, shunting from cable capacitance, resistance drops and thermoelectric potentials. These problems can be largely eliminated by amplifying the signal at the source and altering impedances to levels more suitable for transmission.

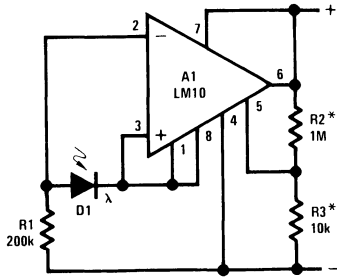
Figure 13 is an example of a remote amplifier. It boosts the output of a high-impedance crystal transducer and provides a low impedance output. No extra wires are needed because DC power is fed in on the signal line.

Figure 14 is a remote signal conditioner that operates in the current mode. A modification of the current source in *Figure 12*, it delivers an output current inversely proportional to sensor resistance. The output can be transmitted over a twisted pair for maximum noise immunity or over a single line with common ground if the signal is slow enough that sufficient noise bypass can be put on the line.

A current-mode signal conditioner for a thermocouple is shown in *Figure 15*. A thermocouple is in reality a two-junction affair that measures temperature differential. Absolute temperature measurements are made by controlling the temperature of one junction, usually by immersing it in an ice bath. This complication can be avoided with cold-junction compensation, which is an absolute thermometer that measures cold-junction temperature and corrects for any deviation from the calibration temperature.

In *Figure 15*, the IC temperature sensor (S1) generates an output proportional to absolute temperature. This current flows through R2, which is chosen so that its voltage drop has the same temperature coefficient as the thermocouple. Thus, changes in cold-junction temperature will not affect calibration as long as it is at the same temperature as S1.

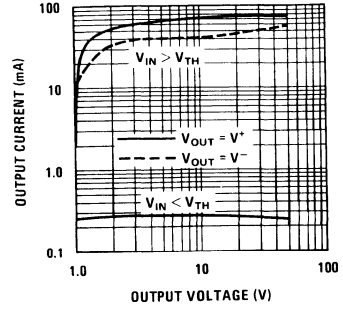
In addition to powering S1, the reference is used to generate an offset voltage such that the output current is within



*provides hysteresis

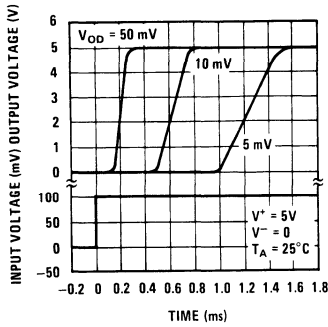
TL/H/7200-6

Figure 6. Two terminal light-level detector with hysteresis



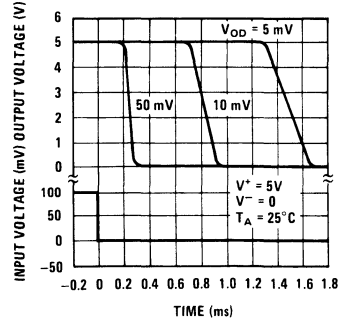
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Figure 7. Terminal Characteristics above and below threshold



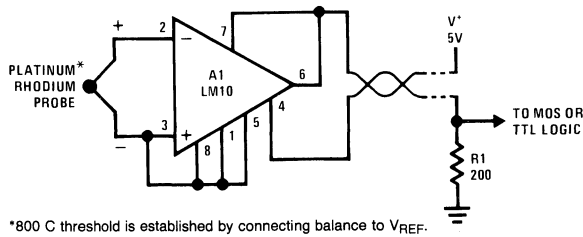
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Figure 8. Comparator response times for various input overdrives



TL/H/7200-9

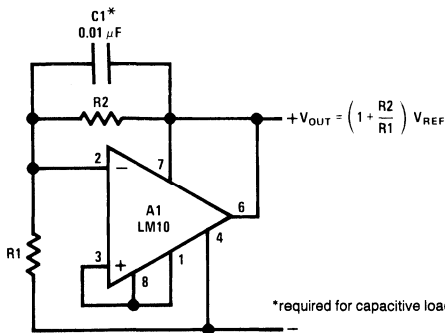
Figure 9. Comparator response times for various input overdrives



*800 C threshold is established by connecting balance to V_{REF}.

TL/H/7200-10

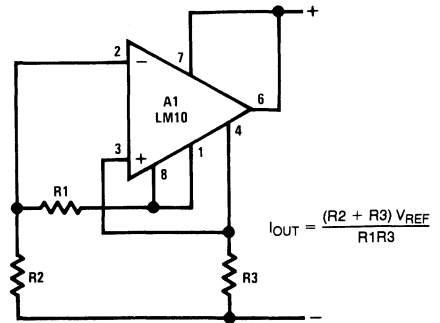
Figure 10. Flame detector



*required for capacitive loading

TL/H/7200-11

Figure 11. Shunt voltage regulator



TL/H/7200-12

Figure 12. Current regulator

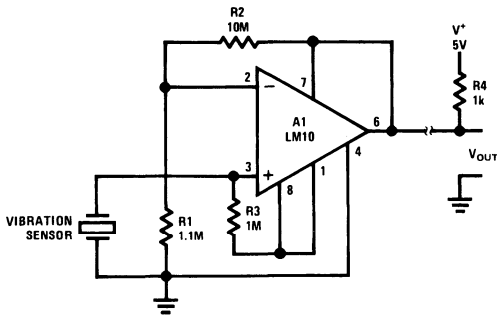


Figure 13. Remote amplifier

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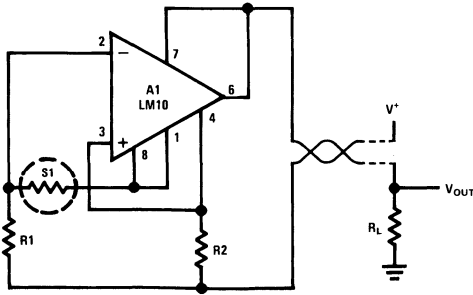


Figure 14. Two-wire transmitter for variable-resistance sensor

TL/H/7200-14

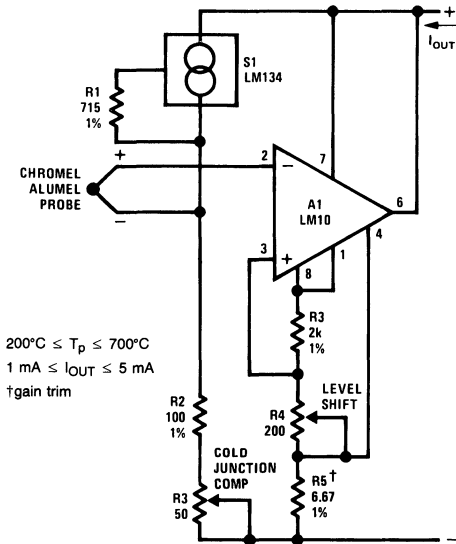


Figure 15. Current transmitter for thermocouple including cold junction compensation

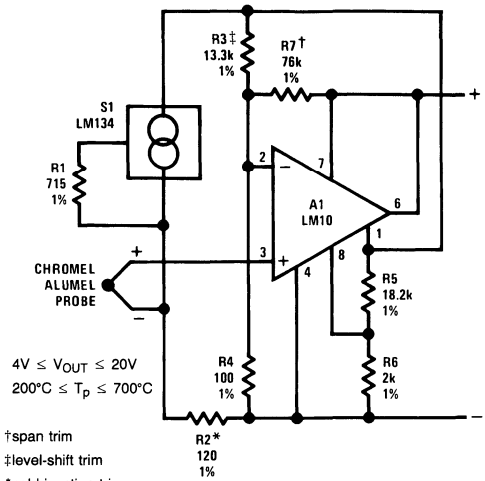
TL/H/7200-15

operating limits for temperatures of interest. It is important that the reference be stable because drift will show up as signal.

The indicated output-current range was chosen because it is one of the standards for two-wire transmission. With the new IC, the dynamic range can be increased by a factor of five in some cases (0.8 mA–20 mA) because the supply current is low. This could be used to advantage with a unidirectional signal where zero must be preserved: the less the offset required to put zero on scale, the less the offset-drift error.

The circuit in Figure 16 is the same thermocouple amplifier operating in the voltage mode. The output voltage range was chosen arbitrarily in that there are no set standards for voltage-mode transmission.

The choice between voltage- and current-mode operation will depend on the peculiarities of the application, although



$4V \leq V_{OUT} \leq 20V$
 $200^{\circ}C \leq T_p \leq 700^{\circ}C$

†span trim
 ‡level-shift trim
 *cold-junction trim

TL/H/7200-16

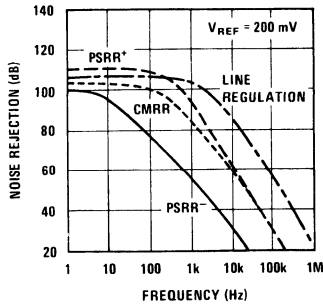
Figure 16. Voltage transmitter for thermocouple, including cold junction compensation

current mode seems to be favored overall. If there is sufficient supply voltage, the dynamic range of both approaches is about equal, provided the transmitter is capable of working at both low voltage and current. This situation could be modified by the voltage and current requirements of the sensor or conditioning circuitry.

With voltage-mode operation, the line resistance can cause error because the DC current that powers the amplifier and sensor circuitry must flow through it. Ground potentials, if they cannot be swamped out with signal swing, would require that twisted pair lines be used. This is not so with current mode.

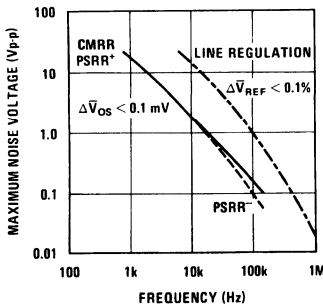
An important consideration is that cable capacitance does not affect the loop stability of the current-mode amplifier. However, large-amplitude noise appearing across the output can give problems. Figure 17 shows the noise rejections of the LM10. The negative supply rejection applies in current-mode operations with the output connected to V^+ . The rejection in this mode is not overly impressive, but transmission can be reduced by bypassing the load resistor. This done, noise slew limiting is the restricting factor in that excessive slew can give rise to a DC error. The maximum

noise amplitude that can be tolerated for a 100 μ V input-referred DC error is plotted in *Figure 18*. These limits are not to be pushed as error increases rapidly above them.



TL/H/7200-17

Figure 17. Noise rejection for the various elements of the circuit



TL/H/7200-18

Figure 18. Noise frequency and amplitude required to give indicated error

With voltage-mode, the circuit reacts to capacitive loading like any other op amp. If there are problems, the load should be isolated with a resistor, taking DC feedback from the load and AC feedback from the op amp output. With the LM10, it is also possible to bypass the output with a single, large capacitor (20 μ F electrolytic) if speed is no consideration.

With bridge sensors, these techniques not only reduce noise problems but only require two leads to both power the bridge and retrieve the signal.

The relevant circuit is shown in *Figure 19*. The op amp is wired for a high-impedance differential input so as not to load the bridge. The reference supplies the offset to put the amplifier in the center of its operating range when the bridge is balanced. It also powers the bridge. The low voltage available from the reference regulator is ideal for driving wire strain gauges that usually have low resistances.

Another form of remote signal processing is shown in *Figure 20*. A logarithmic conversion is made on the output current of a photodiode to compress a four-decade, light-intensity variation into a standard transmission range. The circuit is balanced at mid-range, where R3 should be chosen so that the current through it equals the photodiode current. The log-conversion slope is temperature compensated with R6. Setting the reference output to 1.22V gives a current through R2 that is proportional to absolute temperature, because of D1, so that this level-shift voltage matches the temperature coefficient of R6. C1 has been added so that large area photodiodes with high capacitance do not cause frequency instabilities.

Figure 21 shows a setup that optically measures the temperature of an incandescent body. It makes use of the shift in the emission spectrum of a black body toward shorter wavelengths as temperature is increased. Optical filters are used to split the emission spectrum, with one photodiode being illuminated by short wavelengths (visible light) and the other by long (infrared). The photocurrents are converted to logarithms by Q1 and Q2. These are subtracted to generate an output that varies as the log of the ratio of the illumination intensities. Thus, the circuit is sensitive to changes in spectral distribution, but not intensity. Otherwise, the circuit is quite similar to that in *Figure 20*.

The laws of physics dictate that the output is not a simple function of temperature, so point-by-point calibration is necessary. Sensitivity for a particular temperature range is optimized with the crossover point of the optical filter, longer wavelengths giving lower temperatures.

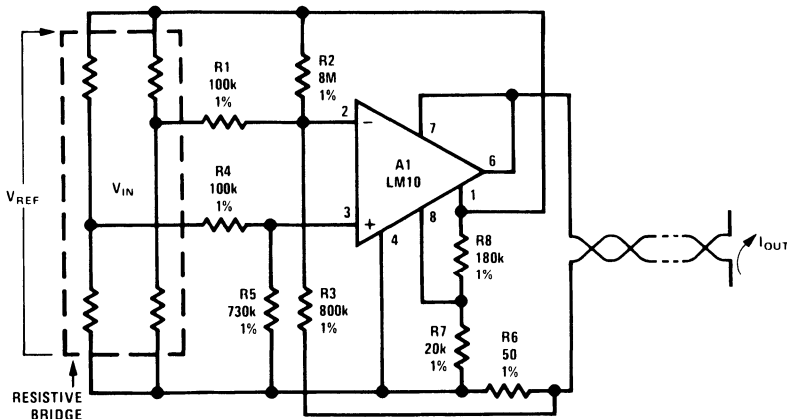


Figure 19. Two-wire transmitter for resistive bridge

TL/H/7200-19

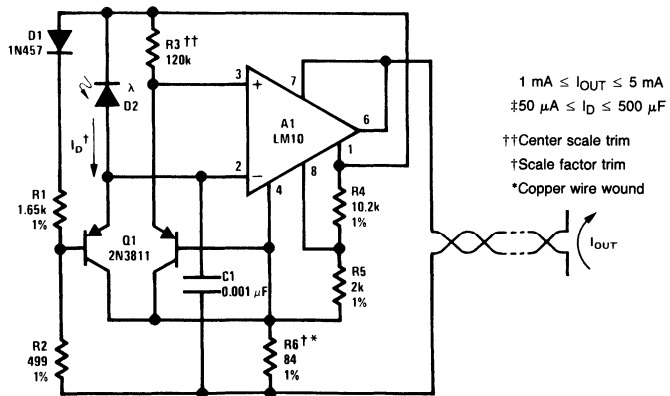


Figure 20. Log converter/transmitter for a photodiode

TL/H/7200-20

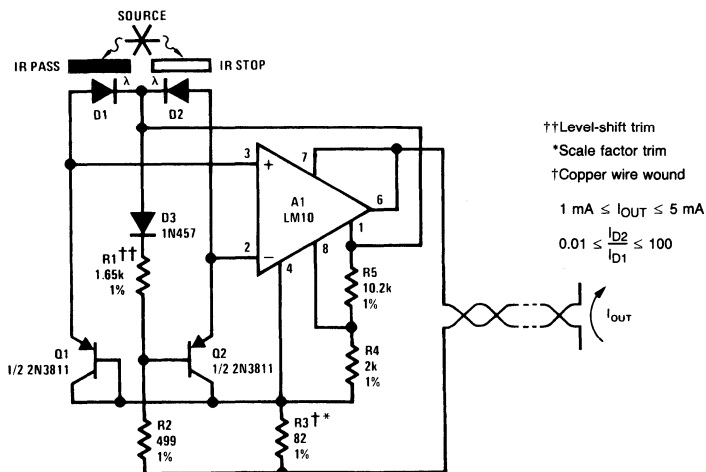


Figure 21. Optoelectric pyrometer with transmitter

TL/H/7200-21

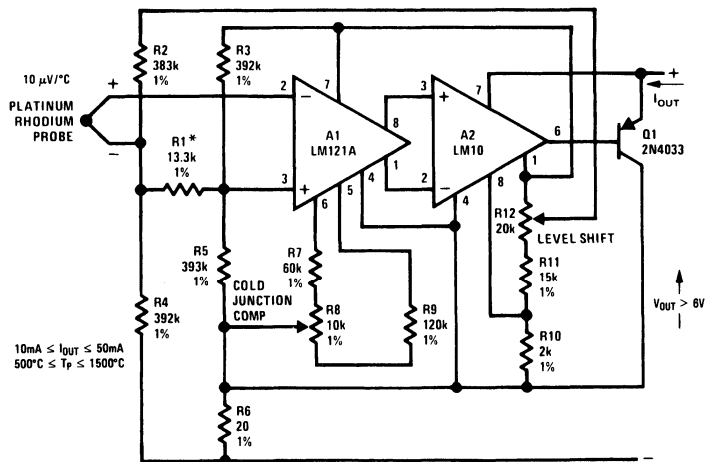


Figure 22. Precision thermocouple amplifier/transmitter

TL/H/7200-22

Figure 22 shows how a low-drift preamplifier can be added to improve the measurement resolution of a thermocouple. The preamp is powered from the reference regulator, and bridge feedback is used to bias the preamp input within its common-mode range. Cold-junction compensation is provided with the offset voltage set into A1, it being directly proportional to absolute temperature.

The maximum drift specification for the preamp is $0.2 \mu\text{V}/^\circ\text{C}$. For this particular circuit, an equal drift component would result for $0.004\%/^\circ\text{C}$ on the reference, $0.001\%/^\circ\text{C}$ mismatch on the bridged-feedback resistors (R2–R4) or $3 \mu\text{V}/^\circ\text{C}$ on the op amp offset voltage. The op amp drift might be desensitized by raising the preamp gain (lowering R7–R9), but this would require raising the output voltage of the reference regulator and the minimum terminal voltage.

In this application, the preamp is run at a lower voltage than standard parts are tested with, and the maximum supply current specified is high. However, there should be no problem with the voltage; and a lower, maximum supply current can be expected at the lower voltage. Even so, some testing may be in order.

regulators

The op amp and voltage reference are combined in Figure 23 to make a positive voltage regulator. The output can be set between 0.2V and the breakdown voltage of the IC by selecting an appropriate value for R2. The circuit regulates for input voltages within a saturation drop of the output (typically $0.4\text{V} @ 20 \text{ mA}$ and $0.15\text{V} @ 5 \text{ mA}$). The regulator is protected from shorts or overloads by current limiting and thermal shutdown.

Typical regulation is about 0.05% load and 0.003%/V line. A substantial improvement in regulation can be effected by connecting the op amp as a follower and setting the reference to the desired output voltage. This has the disadvantage that the minimum input-output differential is increased to a little more than a diode drop. If the op amp were connected for a gain of 2, the output could again saturate. But this requires an additional pair of precision resistors.

The regulator in Figure 23 could be made adjustable to zero by connecting the op amp to a potentiometer on the reference output. This has the disadvantage that the regulation at the lower voltage settings is not as good as it might otherwise be.

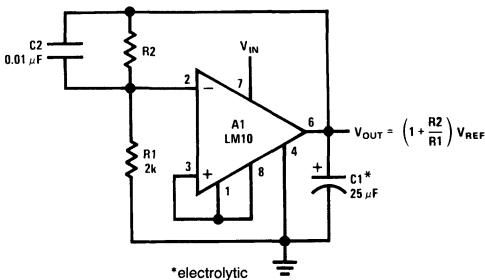


Figure 23. Adjustable positive regulator

TL/H/7200-23

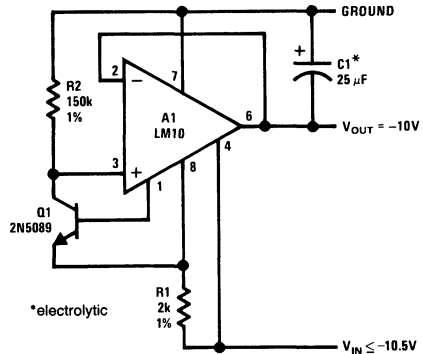
It is also possible to make a negative regulator with this device, as can be seen from Figure 24. A discrete transistor is used to level shift the reference current. This increases the minimum operating voltage to about 1.8V.

Output voltage cannot be reduced below 0.85V because of the common-mode limit of the op amp. The minimum input-output differential is equal to the voltage across R1 plus the saturation voltage of Q1, about 400 mV.

It is necessary that Q1 have a high current gain, or line regulation and thermal drift will be degraded. For example, with a nominal current gain of 100, a 1% drift will be introduced between -55°C and 125°C . With the device specified, drift contribution should be less than 0.3% over the same range; but operation is limited to 30V on the input.

Floating-mode operation can also be useful in regulator applications. In Figure 25, the op amp controls the turn-on voltage of the pass transistor in such a way that it does not see either the output voltage or the supply voltage. Therefore, maximum voltages are limited only by the external transistors.

A three-stage emitter follower is used for the pass transistor primarily to insure adequate bias voltage for the IC under worst-case, high-temperature conditions. With lower output currents Q2 and R4 could be replaced with a diode.



TL/H/7200-24

Figure 24. Negative regulator

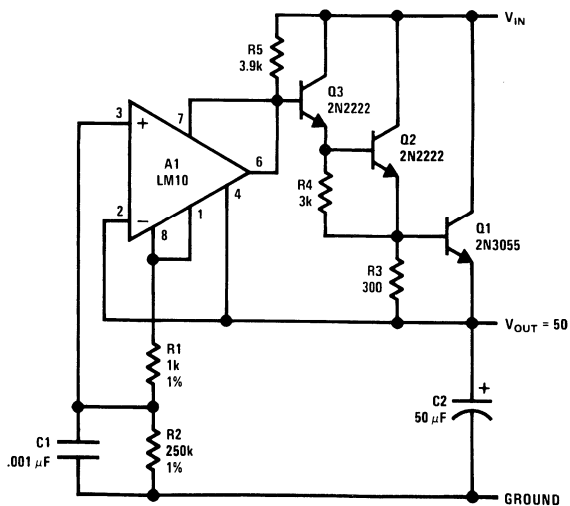
Load regulation is better than 0.01%. Worst-case line regulation is better than $\pm 0.1\%$ for a $\pm 10\text{V}$ change in input voltage. If the op amp output were buffered with a discrete PNP, load and line regulation could be made essentially perfect, except for thermal drift.

Current limiting, although not shown, could easily be provided by the addition of a sense resistor and an NPN transistor. A foldback characteristic could be obtained with two more resistors.

A fully adjustable voltage and current regulator is shown in Figure 26. A second IC (A2) is added to provide regulation in the current-limit mode. Both the regulated voltage and the current can be adjusted close to zero.

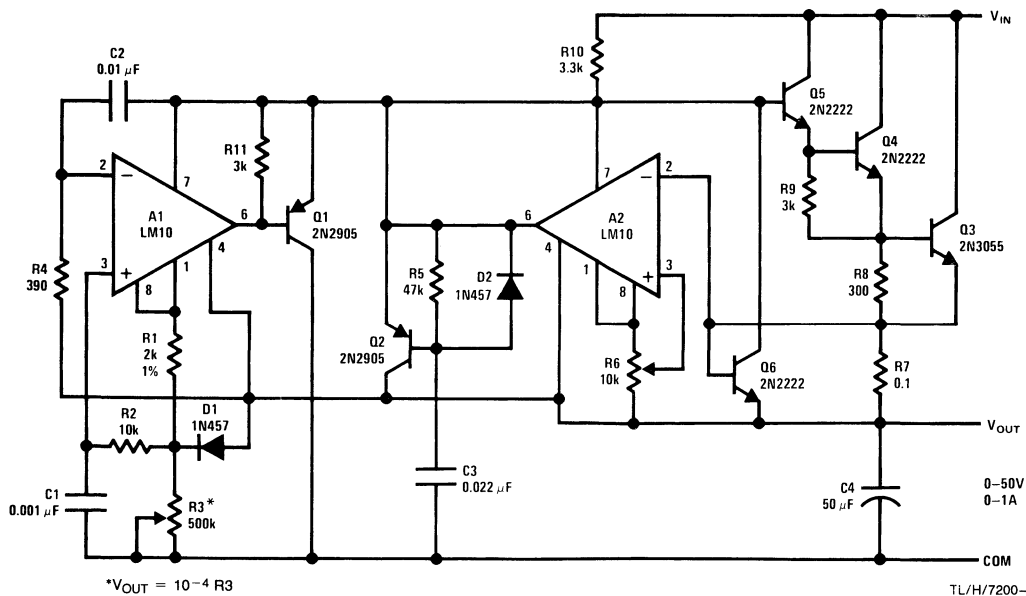
The circuit has a tendency to overshoot when a short circuit is removed. This is suppressed with Q2, R5 and C3, which limit the rate at which the output can rise. Low-level oscillations at the dropout threshold are eliminated with C2 and R4.

The current-limit amplifier takes about $100 \mu\text{s}$ to respond to a shorted output. Therefore, Q6 has been added to limit the peak current during this interval.



TL/H/7200-25

Figure 25. Bootstrapped regulator



TL/H/7200-27

Figure 26. Detailed schematic of an adjustable voltage and current regulator

With high-voltage regulators, powering the IC through the drive resistor for the pass transistors can become quite inefficient. This is avoided with the circuit in *Figure 27*. The supply current for the IC is derived from Q1. This allows R4 to be increased by an order of magnitude without affecting the dropout voltage.

Selection of the output transistors will depend on voltage requirements. For output voltages above 200V, it may be more economical to cascade lower-voltage transistors.

Figure 28 shows a more detailed circuit for a high-voltage regulator. Foldback current limiting has been added to protect the pass transistors from blowout caused by excessive heating or secondary breakdown. This limiting must be fairly precise to obtain reasonable start-up characteristics while conforming to worst case specifications for the transistors. This accounts for the complexity of the circuit.

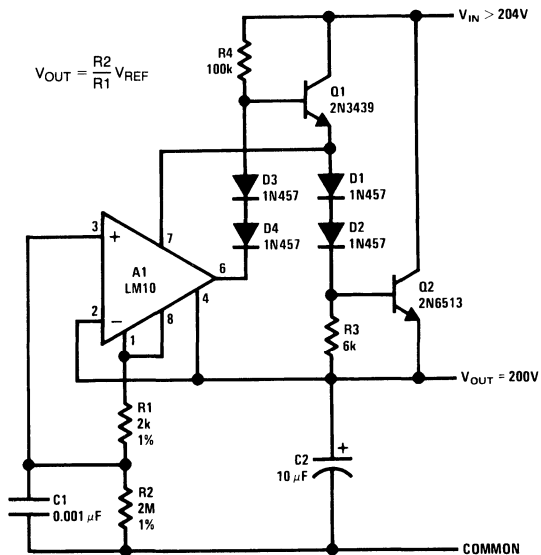


Figure 27. High-voltage regulator

TL/H/7200-26

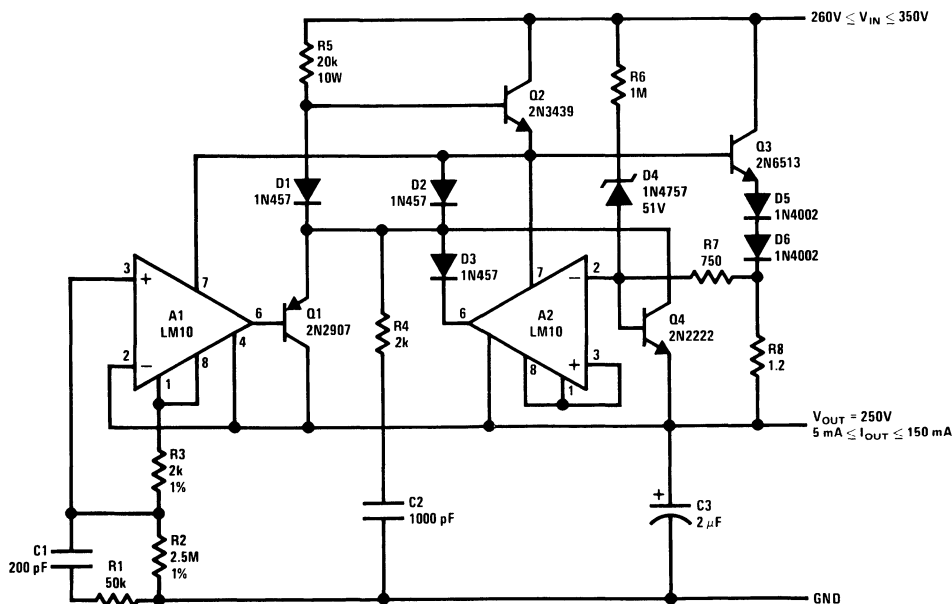


Figure 28. High voltage regulator with foldback current limit

TL/H/7200-29

The output current is sensed across R8. This is delivered to the current limit amplifier through R7, across which the fold-back potential is developed by R6 with a threshold determined by D4. The values given limit the peak power below 20W and shut off the pass transistors when the voltage across them exceeds 310V. With unregulated input voltages above this value, start-up is initiated solely by the current through R5. Q4 is added to provide some control on current before A2 has time to react.

The design could be considered overly conservative, but this may not be inappropriate considering the start of the art for high-voltage power transistors. Their maximum operating current is in the tens of milliamperes at maximum voltage. Cutting off the power transistor before the maximum input-output voltage differential is reached can cause start-up problems, depending on the nature of the load (those that tend toward a constant-current characteristic being worst).

If a tighter design is required for start-up, the values of R6 and D4 can be altered. In addition, R5 can be lowered, although it may be necessary to add a PNP buffer to A2 in place of D3.

The leakage current of Q3 can be more than several milliamperes. That is why a hard turn-off is provided with D2.

The circuit is stable with an output capacitor greater than about 2 μF . Spurious oscillations in current limit are suppressed by C2 and R4, while a strange, latch-mode oscillation coming out of current limit is killed with C1 and R1.

Switching regulators operating directly from the power lines are seeing increased usage not only because of the reduced weight and size when compared to a 60 Hz transformer but also because they operate over a wide voltage range giving a regulated output with reasonable efficiency. Electrical isolation of the load is generally required in these applications for reasons of safety. Therefore, if precise regulation is needed on the secondary, there must be some way of transmitting the error signal back to the primary.

Figure 29 shows a design that provides this function. The IC serves as a reference and error amplifier, transmitting the error signal through an optical coupler. The loop gain may be controlled by the addition of R1, and C1 and R5 may be added to develop the phase lead that is helpful in frequency stabilizing the feedback.

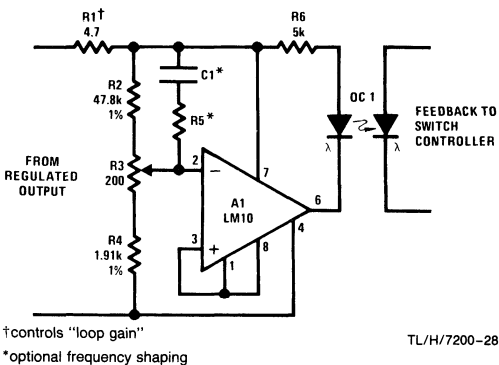


Figure 29. Isolated sensor for an off-line switching regulator

voltage level indicators

In battery-powered circuitry, there is some advantage to having an indicator to show when the battery voltage is high enough for proper circuit operation. This is especially true for instruments that can produce erroneous data.

The battery status indicator drawn in Figure 30 is designed for a 9V source. It begins dimming noticeably below 7V and extinguishes at 6V. If the warning of incipient battery failure is not desired, R3 can be removed and the value of R1 halved.

A second circuit that also regulates the current through the light-emitting diode is shown in Figure 31. This is important so that adequate current is available at minimum voltage, but excessive current is not drawn at maximum voltage. Current regulation is accomplished by using the voltage on the balance pin (5) as a reference for the op amp. This is controlled at approximately 23 mV, independent of temperature, by an internal regulator. When the voltage on the reference-feedback terminal (8) drops below 200 mV, the reference output (1) rises to supply the feedback voltage to the op amp through D2, so the LED current drops to zero.

The minimum threshold voltage for these circuits is basically limited by the bias voltage for the LEDs. Typically, this is 1.7V for red, 2V for green and 2.5V for yellow. These two circuits can be made to operate satisfactorily for threshold voltages as low as 2V if a red diode is used. However, the circuit in Figure 31 is preferred in that difficulties caused by voltage change across the diode biasing resistor are eliminated.

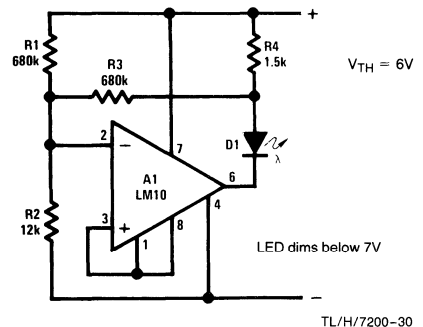


Figure 30. Battery status indicator

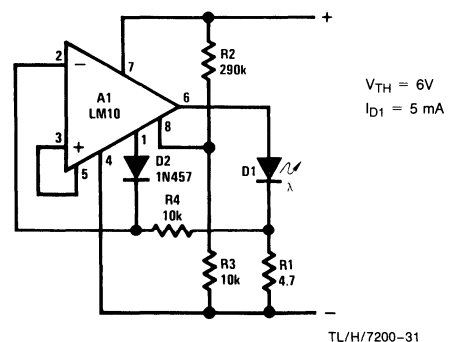


Figure 31. Battery level indicator with regulated LED current

When operating with a single cell, it is necessary to incorporate switching circuitry to develop sufficient voltage to drive the LED. A circuit that accomplishes this is drawn in Figure 32. Basically, it is a voltage-controlled asymmetrical multivibrator with a minimum operating threshold given by

$$V_{TH} = \frac{R4 (R1 + R2)}{R1 (R3 + R4)} V_{REF} \quad (1)$$

Above this threshold, the flash frequency increases with voltage. This is a far more noticeable indication of a deteriorating battery than merely dimming the LED. In addition, the indicator can be made visible with considerably less power drain. With the values shown, the flash rate is 1.4 sec^{-1} at 1.2V with a $300 \mu\text{A}$ drain and 5.5 sec^{-1} at 1.55V with $800 \mu\text{A}$ drain. Equivalent visibility for continuous operation would require more than 5 mA drain.

The maximum threshold voltage of this circuit is limited because the LED can be turned on directly through R5. Once this happens, the full supply voltage is not delivered to R2, which is how the threshold is determined. This problem can be overcome with the circuit illustrated in Figure 33. This design repositions the indicator diode, requiring an input voltage somewhat greater than the diode bias voltage needed.

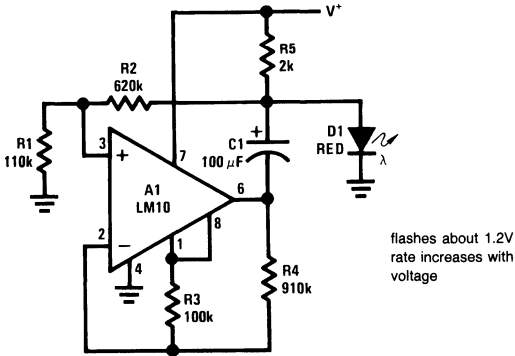


Figure 32. Undervoltage indicator for single cell

TL/H/7200-32

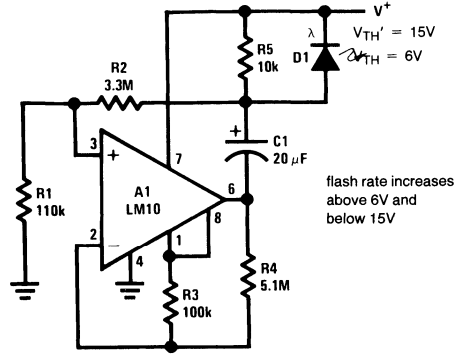


Figure 33. Double-ended voltage monitor

TL/H/7200-33

This circuit has the added feature that it can sense an over-voltage condition. The lower activation threshold is given by equation (1), but above a threshold,

$$V_{TH}' = \frac{R4 (R1 + R2) V_{REF}}{R1 (R3 + R4) - R3 (R1 + R2)} \quad (2)$$

oscillation again ceases. (Below V_{TH} the op amp output is saturated negative while above V_{TH}' it is saturated positive.) The flash rate approaches zero near either limit.

The minimum/maximum limits possible with this circuit along with the possibility of estimating the proximity to the limit and the low power drain ($\sim 500 \mu\text{A}$) make it attractive for a variety of simple, low-cost test equipment. This could include everything from the measurement of power-line voltage to in-circuit testers for digital equipment.

meter circuits

One obvious application for this IC is a meter amplifier. Accuracy can be maintained over a 15°C to 55°C range for a full-scale sensitivity of 10 mV and 100 nA using the design in Figure 34. In fact, initial tests indicate negligible zero drift with 1 mV and 10 nA sensitivities, although balancing is troublesome with low-cost potentiometers. Offset voltage error is nulled with R5, and the bias current can be balanced out with R4. The zeroing circuits operates from the reference output and are essentially unaffected by changes in battery voltage, so frequent adjustments should not be necessary.

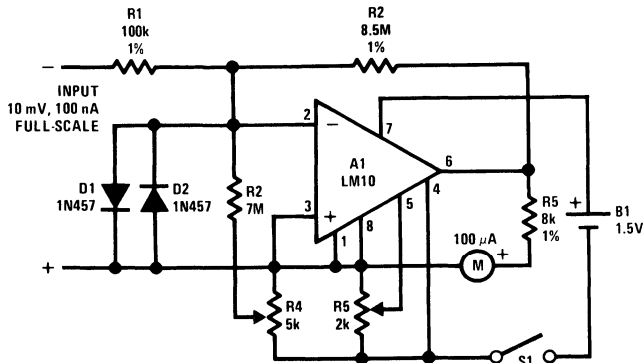


Figure 34. Meter amplifier

TL/H/7200-34

Under overload conditions, the current delivered to the meter is kept well in hand by the limited output swing of the op amp. The same is true for polarity reversals. Input clamp diodes protect the circuit from gross overloads.

Total current drain is under 0.5 mA, giving an approximate life of 3–6 months with an "AA" cell and over a year with a "D" cell. With these lifetimes an ON/OFF switch may be unnecessary. A test switch that converts to a battery-test mode may be of greater value.

If the meter amplifier is used in building a multimeter, the internal reference can also be used in measuring resistance. This would make the usual frequent recalibration with falling cell voltage unnecessary.

A portable light-level meter with a five-decade dynamic range is shown in Figure 35. The circuit is calibrated at mid-range with the appropriate illumination by adjusting R2 such that the amplifier output equals the reference and the meter is at center scale. The emitter-base voltage of Q2 will vary with supply voltage; so R4 is included to minimize the effect on circuit balance. If photocurrents less than 50 nA are to be measured, it is necessary to compensate the bias current of the op amp.

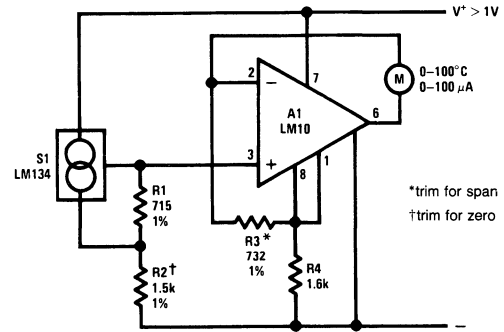
The logging slope is not temperature compensated. With a five-decade response, the error at the scale extremes will be about 40% (a half stop in photography) for a $\pm 18^\circ\text{C}$ temperature change.

If temperature compensation is desired, it is best to use a center-zero meter to introduce the offset, rather than the

reference voltage. This done, temperature compensation can be obtained by making the resistor in series with the meter a copper wire-wound unit.

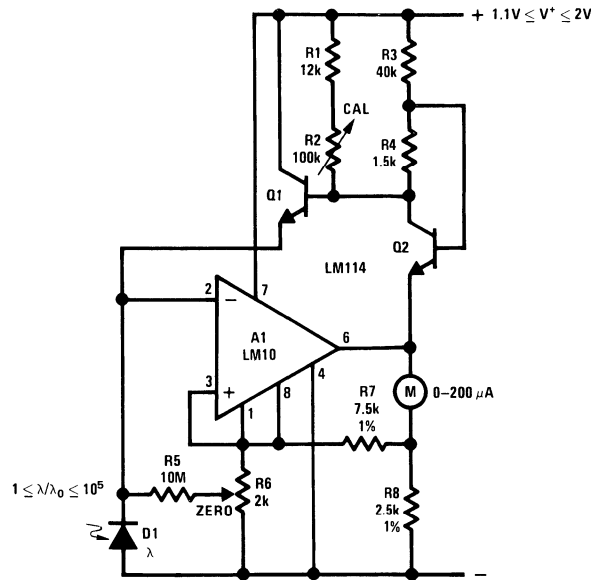
If this design is to be used for photography, it is important to remember that silicon photodiodes are sensitive to near infrared, whereas ordinary film is not. Therefore, an infrared-stop filter is called for. A blue-enhanced photodiode or an appropriate correction filter would also give best results.

An electronic thermometer design, useful in the range of -55°C to 150°C , is shown in Figure 36. The sensor, S1, develops a current that is proportional to absolute temperature. This is given the required offset and range expansion by the reference and op amp, resulting in a direct readout in either $^\circ\text{C}$ or $^\circ\text{F}$.



TL/H/7200-36

Figure 36. Electronic thermometer



TL/H/7200-35

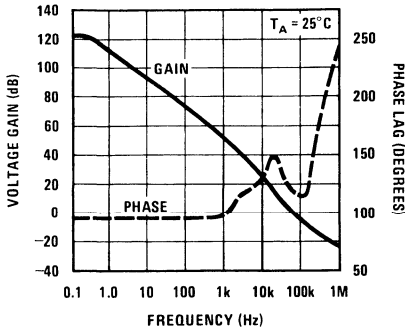
Figure 35. Logarithmic light-level meter

Although it can operate down to 1V with better than 0.5°C accuracy, the LM134 is not tested below 1.5V. Maverick units were observed to develop a 1°C error going from 1.5V to 1.2V. This should be kept in mind for high-accuracy applications.

The thermocouple transmitter in *Figure 15* can easily be modified to work with a meter if a broader temperature range is of interest. It would likewise be no great problem adapting resistance or thermistor sensors to this function.

audio circuits

As mentioned earlier, the frequency response of the LM10 is not as good as might be desired. The frequency-response curve in *Figure 37* shows that only moderate gains can be realized in the audio range. However, considering the reference, there are two independent amplifiers available, so that reasonable overall performance can be obtained.



TL/H/7200-37

Figure 37. Open loop frequency response

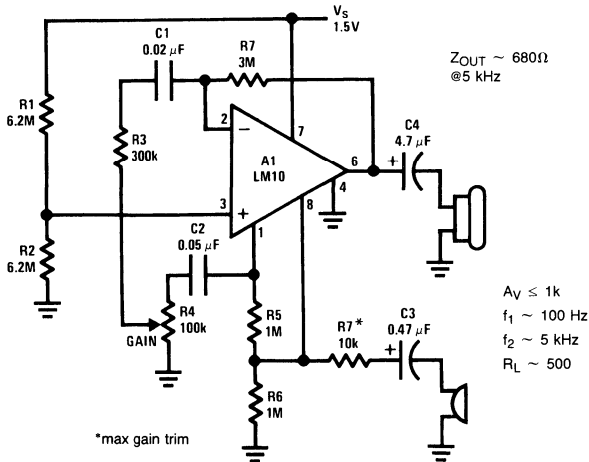
This is illustrated with the microphone amplifier shown in *Figure 38*. The reference, with a 500 kHz unity-gain bandwidth, is used as a preamplifier with a gain of 100. Its output is fed through a gain-control potentiometer to the op amp which is connected for a gain of 10. The combination gives a 60 dB gain with a 10 kHz bandwidth, unloaded, and 5 kHz loaded at 500Ω. Input impedance is 10 kΩ.

Potentially, using the reference as a preamplifier in this fashion can cause excess noise. However, because the reference voltage is low, the noise contribution, which adds root-mean-square, is likewise low. The input noise voltage in this connection is 40–50 nV/√Hz, about equal to that of the op amp.

One point to observe with this connection is that the signal swing at the reference output is strictly limited. It cannot swing much below 150 mV nor closer than 800 mV to the supply. Further, the bias current at the reference feedback terminal lowers the output quiescent level and generates an uncertainty in this level. These facts limit the maximum feedback resistance (R5) and require that R6 be used to optimize the quiescent operating voltage on the output. Even so, the fact that limited swing on the preamplifier can reduce maximum output power with low settings on the gain control must be considered.

In this design, no DC current flows in the gain control. This is perhaps an arbitrary rule, designed to insure long life with noise-free operation. If violations of this rule are acceptable, R5 can be used as the gain control with only the bias current for the reference amplifier (<75 nA) flowing through the wiper. This simplifies the circuit and gives more leeway on getting sufficient output swing from the preamplifier.

The circuit in *Figure 38* can also be modified to provide two-wire transmission for a microphone output.



TL/H/7200-38

Figure 38. Microphone amplifier

conclusions

The applications described here show that some truly unique functions can be performed by the LM10 because of the low-voltage capability and floating mode operation. Among these are accurate, two-terminal comparators that interface directly with most logic forms. They can also drive SCRs in control circuits using low-level sensors like photodiodes or thermocouples, although this was not explored here.

Two-wire transmitters for analog signals were shown to work with a variety of transducers, even to the extent of remotely performing computational functions. These might be used for anything from a microphone preamplifier to a strain gauge measuring stress at some remote location in an aircraft. The power requirements of this IC are modest enough to insure a wide dynamic range and permit operation with lower-voltage supplies.

The IC also proves to be quite useful in regulator circuits, as might be expected from a combined op amp and voltage reference. It makes an efficient series regulator at low voltages. And as a low-level, on-card regulator, it offers greater precision than existing devices. It is also easily applied as a shunt regulator or current regulator.

In the floating mode, it operates with the precision required of laboratory supplies, as either a voltage or current regulator. Maximum output voltage is limited only by discrete pass

transistors, because the control circuit sees, at most, a couple volts. Therefore, output voltages of several hundred volts are entirely practical.

A few examples were given of amplifiers and signal conditioners for portable instruments. Emphasis was placed on single-cell operation as this gives the longest life at lowest cost from the smallest power source. The IC is well suited to single-supply operation, where it can be used in any number of standard applications. This can be put to use in digital systems where some linear functions must be performed. The availability of a reference allows precise level shifting or comparisons even when the supply is poorly regulated. The reference can also be used to create an elevated pseudo-ground so that split-supply techniques can be used.

Even when split supplies are available, the increased output capability (40V @ 20 mA) coupled with lower power consumption could well recommend the LM10. This is combined with the more satisfactory fault protection provided by thermal limiting.

acknowledgement

The authors would like to thank Dick Wong for his assistance in building and checking out the applications described here.

references

1. R. J. Widlar, "Low Voltage Techniques," *IEEE J. Solid-State Circuits*, Dec. 1978.

*** See Addendum(TP-14) that follows
this Application Note.**

Low Voltage Techniques*

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National Semiconductor
 Addendum to AN-211
 (formerly TP-14)



Abstract. A micropower operational amplifier is described that will operate from a total supply voltage of 1.1V. The complementary Class-B output can swing within 10 mV of the supplies or deliver ± 20 mA with 0.4V saturation. Common-mode range includes V^- , facilitating single-supply operation. Otherwise, DC performance compares favorably with that of the LM108. An adjustable-output voltage reference is also presented that uses a new technique to eliminate the bow usually found in the temperature characteristics of the band-gap reference. Minimum supply is 1V, and typical drift is 0.002%/°C.

Introduction

The intrinsic operating voltage limit of bipolar ICs is only 100–200 mV greater than the emitter-base voltage of the transistors. To date, this limit has been pushed only with digital circuitry and relatively simple linear devices. This paper will deal with techniques for fabricating such devices as operational amplifiers, comparators, regulators and voltage references that work from a voltage as low as that supplied by a single nickel-cadmium cell.

Field-effect transistors have been considered for low-voltage applications because their operating voltage can theoretically be made less than that of bipolar transistors. Although their transconductance equals that of bipolar devices at very-low currents, it is considerably less even at moderate current densities. This limits FETs to such functions as input stages where the operating current is relatively low and well controlled.

A combined op amp, voltage reference and reference amplifier was chosen as a design example. A functional diagram is given in *Figure 1*. This configuration will serve to demonstrate that the usefulness of low-voltage operation goes beyond battery-powered equipment. It can be used in a floating mode, independent of fixed supplies. This is illustrated both by the floating voltage regulator in *Figure 2*, where the IC operates from the drive voltage to the pass transistors, and the remote comparator in *Figure 3*, where the IC functions as a 2-terminal device, driving TTL logic directly. A wide range of similar applications have been developed and are discussed elsewhere.¹

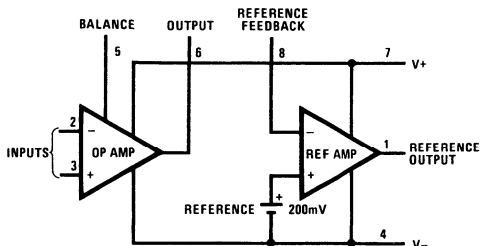
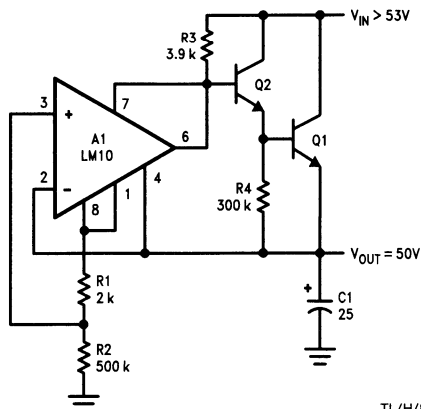


Figure 1. Functional diagram of the design example

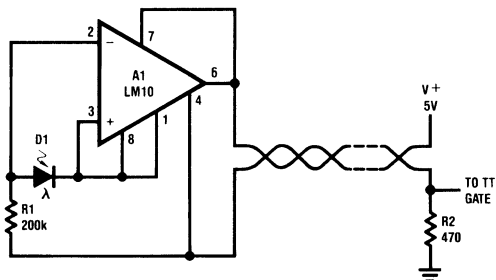
*Reprinted from *IEEE Journal of Solid-State Circuits*, December, 1978.

†This work was performed under contract to National Semiconductor Corporation, Santa Clara, California.



TL/H/8723-2

Figure 2. High voltage regulator with bootstrapped control amplifier



TL/H/8723-3

Figure 3. Light level detector driving TTL directly over 2-wire line

Some small advantage might be gained by limiting operation to low voltages. This is overshadowed by the benefits of making a general-purpose IC. Therefore, it was decided to use standard processing with maximum operating voltages limited only by the BV_{CEO} of the transistors (50V–60V).

Ion-implanted resistors were incorporated to obtain the necessary high values for micropower operation. They also have the advantage that, with proper design, the speed/power tradeoffs can be determined at the final stages of processing by varying the implant dose. However, the advisability of doing this on a production basis has yet to be established.

operational amplifier design

A simplified schematic of the op amp is given in *Figure 4*. Lateral PNP transistors are used on the input because this is the easiest way to secure operation at common-mode voltages equal to the negative supply voltage. Processing that yields typical PNP current gains greater than 100 at low

currents has been in production for nearly 10 years. These lateral transistors also have relatively constant current gain over temperature, giving lower bias-current drift than NPNs. Protective resistors have been included in the input leads so that current does not become excessive when the inputs are forced below the negative supplies, forward biasing the base tubs.

Offset nulling is accomplished by connecting the balance terminal to a variable voltage derived from the reference output. Both the input-stage current and the reference are tightly regulated over temperature, and the resistance of the adjustment potentiometer can be made very much lower than the resistance looking back into the balance pin. Therefore, offset nulling can produce a minimum-drift condition.

Proceeding through the circuit, the input stage is buffered by vertical PNP followers, Q3 and Q4. This differential signal is converted to single ended by Q5 and Q6 and fed to the base of the second-stage amplifier Q7.

This configuration is not inherently balanced in that the emitter-base voltage of the vertical PNPs is required to match that of the NPNs. As will be seen, the final circuit does include circuitry to correct for the expected variations.

From the collector of Q7, the signal splits, driving separate halves of the complementary Class-B output stage. The NPN output transistor, Q25, is driven through Q13 and Q14. This complementary emitter follower arrangement provides the necessary current gain without requiring the extra bias voltage of a Darlington connection. This is essential in realizing minimum-voltage operation.

Base drive for the NPN output transistor is initially supplied by Q12, but a boost circuit has been added to increase the available drive as a function of load current. This is accomplished with Q24 in conjunction with a current inverter. The inclusion of R23 prevents gross over boosting.

The boost amounts to controlled positive feedback. It does tend to reduce dead zone and linearize gain. Excess boost current is absorbed by Q14, which presents a low enough drive impedance so that the voltage transfer function from its base does not exhibit a negative-gain characteristic. Considerable experience with this and similar boost circuits shows that they do not unfavorably alter frequency response, at least below a few megahertz.

Drive for the PNP half of the output is somewhat more complicated. Again, a compound buffer, Q15 and Q16, is used, although to maintain circuit balance rather than for current gain. The signal proceeds through two inverters, Q17 and Q19, to obtain the correct phase relationship and DC level shift, before it is fed to the PNP output transistor, Q28.

This path has three common-emitter stages; and, potentially, much higher gain than the NPN side. The gain is equalized, however, by the shunting action of Q18-R19 and Q21-R22 as well as negative feedback through Q23.

When the output PNP saturates, Q20 serves to limit its base overdrive with a feedback path to the base of Q17. This is also important to the floating-mode operation of *Figures 2* and *3* in that it disables the PNP drive circuitry when the op amp output is connected to V^+ .

The complete schematic of the operational amplifier in *Figure 5* shows the remaining design features. The lower collector on Q1 is outside the normal collector. Its current is quite low until the positive common-mode limit is exceeded, saturating the normal collector of Q1. The auxiliary collector picks up the re-injected current in saturation, which is routed through Q4 to the collector of Q3. When, for example, the

amplifier is connected as a follower, this prevents false outputs when the common-mode limit is exceeded. In normal operation, the low-level leakage from the auxiliary collector is evenly divided between the input-stage collectors because the voltage drop across R4 is small.

An extra emitter on Q2 working with Q18 performs a similar function when the negative common-mode limit is exceeded on the inverting input, insuring that the output will be in positive saturation. The non-inverting input is also arranged to give a proper output when the input is driven below V^- .

As mentioned earlier, the optimum collector current of Q13 will depend on the V_{BE} difference between NPN and PNP transistors (Q9-Q10 and Q7-Q13). This is compensated by generating a similar difference current with Q21 and Q22 then processing it with Q19, Q17 and Q15 to generate the required complement in the collector circuit of Q13.

The output stage has been designed to deliver a minimum output current of ± 20 mA with a typical saturation voltage of ± 0.4 V. Conventional current limiting cannot be used without significantly increasing the saturation voltage. Since the current gain of lateral PNPs falls off severely at high current and high temperature, it is only necessary to limit the driver current. This is done with R42 and R43, with Q44 insuring that supply current does not become excessive if the BV_{CEO} of Q45 is exceeded on supply transients.

Current limit for the NPN side is done with Q51, Q53 and associated circuitry. In addition, Q49 and Q52 have been added to limit the over boost, should it become larger than can be handled by Q35.

The maximum operating voltage and output current of this device are high enough that current limiting cannot be expected to prevent excessive die temperature, especially with worst-case conditions. Therefore, thermal overload protection has been provided. Die temperature is sensed with Q25, and Q26 introduces hysteresis into the limiting characteristic. The cut out temperature is designed to be 165°C , with operation resuming when the die cools to 155°C . The NPN and PNP halves are shut off by Q27 and Q29, respectively.

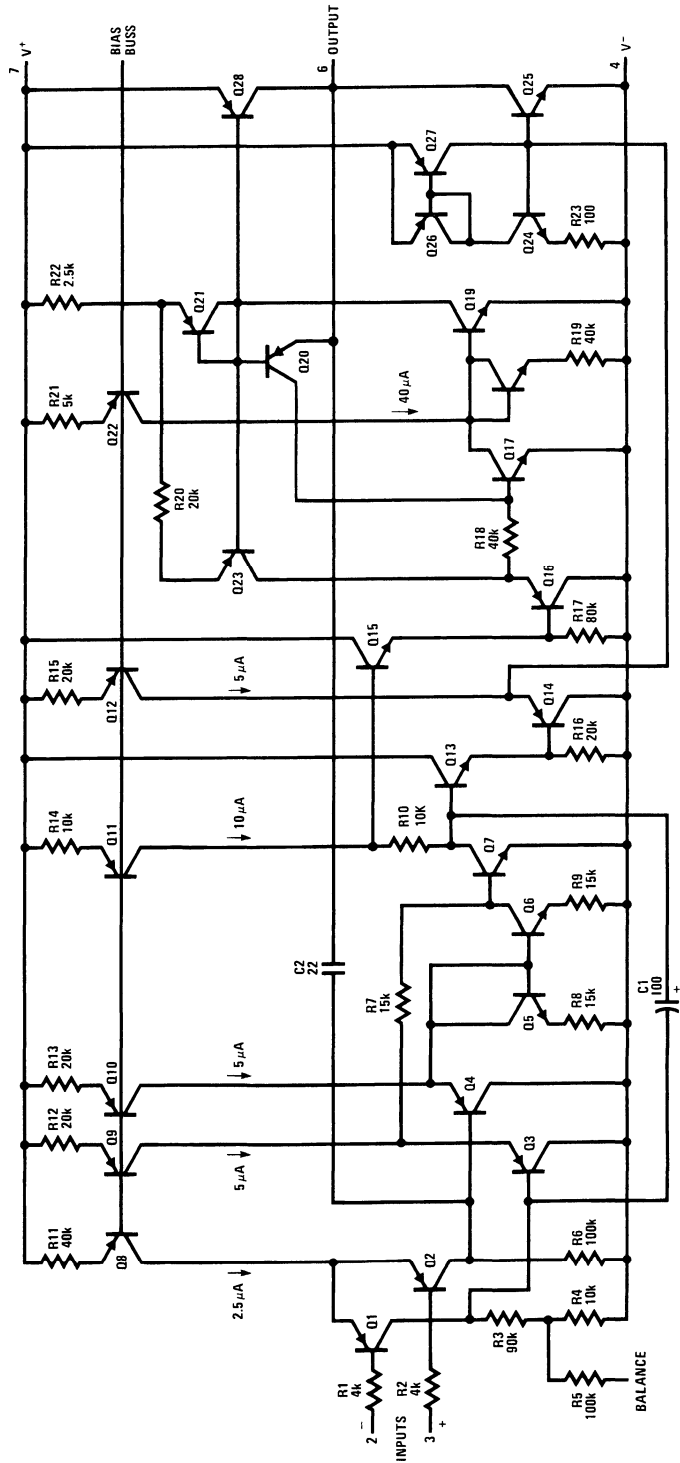
Output stage quiescent current is determined by the voltage across R16 and various device geometries. The current is stabilized for varying supply voltage by connecting Q33 in cascode with Q30 and by the addition of Q31 and Q32, which tend to compensate for the collector voltage sensitivity of emitter-base voltage.

At temperatures approaching thermal limit, Q40 must operate beyond the threshold of saturation. The addition of Q39, which is actually a lateral PNP collector ring surrounding the base of Q40, produces a voltage drop across R34 to compensate for the drop across R35 caused by excess base current.

frequency compensation

With feedback amplifiers, the ability to frequency compensate a particular design is generally the bottom line in determining its usefulness. Considering the number of stages involved and the fact that the drive paths for the PNP and NPN output transistors are entirely different, one might rightly conclude that frequency compensation would be difficult.

As much of the frequency compensation network as can be explained in a straightforward manner is shown in the simplified schematic of *Figure 4*. Overall compensation is provided by a MOS capacitor, C2, between the output and the collector of an input transistor. Within this loop, a diffused capacitor, C1, rolls off the gain of Q7, breaking back out where $X_{C1} = R6$.



TL/H/8723-5

Figure 4. Essential details of the op amp

TL/H/8723-4

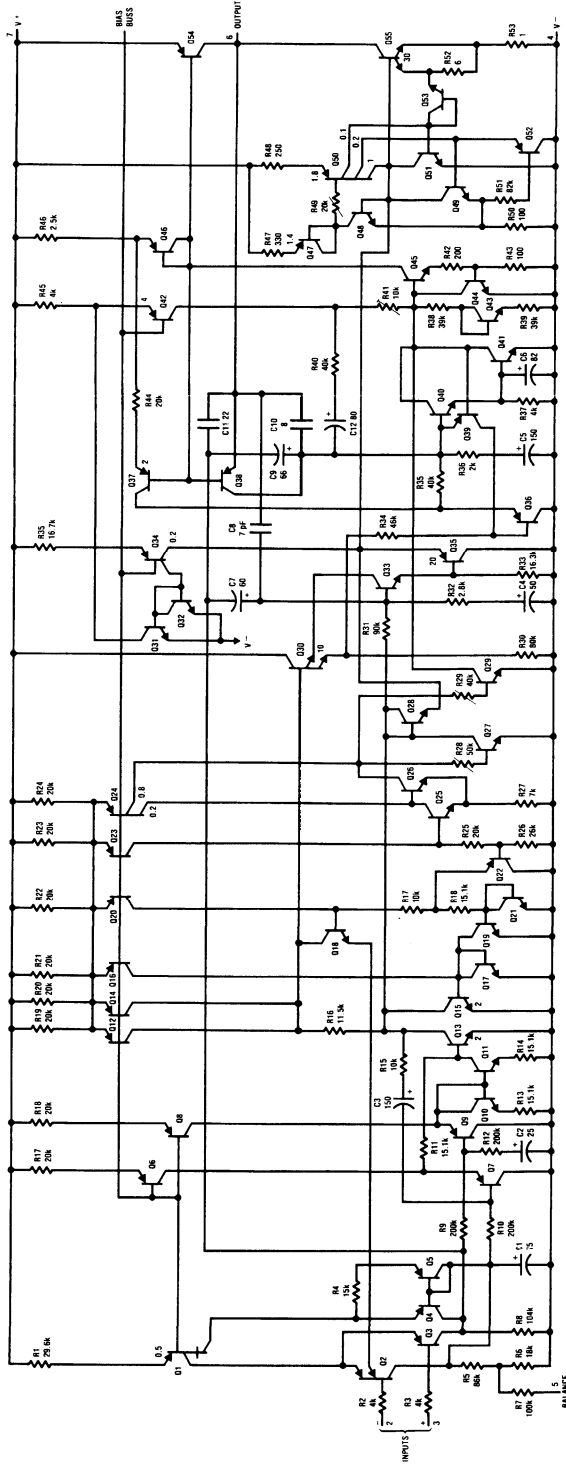


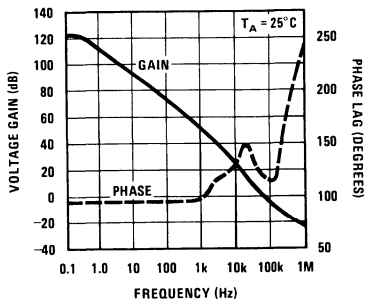
Figure 5. Complete op amp schematic

Referring again to the complete schematic, it can be seen that things are not really that simple. The function of the feed-forward capacitors, C7 and C9, seems obvious. But remaining compensation components were added as a result of breadboard tests which checked the circuit over temperature with full range of load currents and operating voltages, while varying the resistive and reactive components of load impedance.

A detailed theoretical analysis of the compensation seems overly complicated, considering the number of minor feedback loops involved. This conclusion is supported by the fact that impedance levels in portions of the circuit vary considerably with load current and so does the effect of the frequency-shaping circuits.

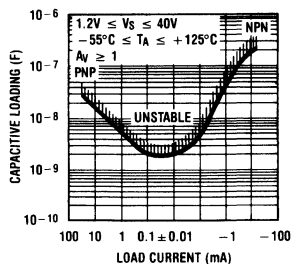
Results show the circuit to be stable. For one, no significant differences were found between the breadboard and the IC. This is not overly surprising considering the frequencies involved. Further, varying the sheet resistance of the implant resistors over a 5:1 range showed only that higher resistors made slower amplifiers. Varying NPN current gain over a 4:1 range had little effect on AC characteristics.

Figure 6 is a plot of the open-loop frequency-phase plot of the amplifier. It can be seen that the response does not exactly follow a 6 dB/octave curve. In voltage follower applications, the excess phase shift will cause about 3 dB peaking around 35 kHz. This is of little consequence in that the circuit is not intended for operation above the audio range. What is important is that there are no stability problems for capacitive loads in excess of 1000 pF over the entire operating range of the device. This is illustrated by the plot in Figure 7.



TL/H/8723-6

Figure 6. Open loop frequency response of the op amp



TL/H/8723-7

Figure 7. Plot of capacitive loading required to produce excessive transient ringing in the op amp

A tally of the compensation capacitance for the entire circuit gives a total value of 1000 pF. Nearly all of this is diffused emitter-isolation capacitance (~ 1 pF/mil²), and most is diffused into the isolation walls, requiring no extra die area. The reverse bias on diffused capacitors is less than a diode drop, minimizing the effect of soft junctions. This is but one of the advantages of a design where most of the circuit sees only low voltage.

reference and internal regulators

The reference and the internal biasing circuitry are shown in Figure 8. The design of the band gap reference² (using Q71 and Q72) is unconventional in its configuration and because it compensates for the second-order nonlinearities in the emitter-base voltage as well as those introduced by the temperature drift of the resistors. Thus, the uncompensatable bow in the thermal characteristics of standard devices can be minimized and better temperature stability obtained.

Ignoring the voltage drop across R61 for the moment, the reference voltage developed at the emitter of Q71 is equal to the voltage drop across R62 plus the difference in the emitter-base voltages of Q71 and Q72. The former component is proportional to the emitter-base voltage of Q72 and has a negative temperature coefficient while the latter has a positive temperature coefficient. First order temperature compensation can be obtained by adding these voltages in the proper proportions.

The collector current of Q72 is essentially the output current of the top collector on Q68 less the current through the R62-R64-R66 divider. If the current-source current (Q68) is invariant with temperature and the divider current varies as emitter-base voltage, the collector current of Q72 can be made proportional to absolute temperature. This done, the value of R61 can be set so that the voltage on the collector of Q72 does not change appreciably for small changes in current-source current.

Drift-curvature correction is obtained by maintaining the collector current of Q71 nearly constant while that of Q72 varies directly as temperature. This makes the reference output rise at a rate increasing with temperature. Resistor drift and emitter-base voltage non-linearities have the opposite effect. Near-exact cancellation can be obtained with the proper tap on R64/R66.

The reference amplifier is pretty much a conventional design using a PNP pair (Q66-Q69) for the input, with a NPN current inverter (Q67-Q70) supplying gain and converting to single ended operation. Additional gain is supplied by Q64, and its output is buffered by Q62 and Q56. Frequency rolloff is provided with C12 and R60, with a lead established by feed-forward through C13 and R59.

The quiescent level of the Class-A output stage is set by Q57. The output current is primarily limited by the current gain of Q56. Current limiting is added with Q58, Q61 and R54 to control the short circuit current for supply voltages above BV_{CE0} . This was considered necessary because the thermal limiting does not operate on the reference amplifier. A clamp, Q59, has been added to insure that the emitter-base junction of Q56 does not break over if the reference output is shorted to V^+ .

Precise regulation of the op amp input stage current is required to minimize drift when the recommended offset balancing scheme is used. It also turns out to be of considerable value in normalizing overall operation over the 40:1 range of supply voltage specified for the device.

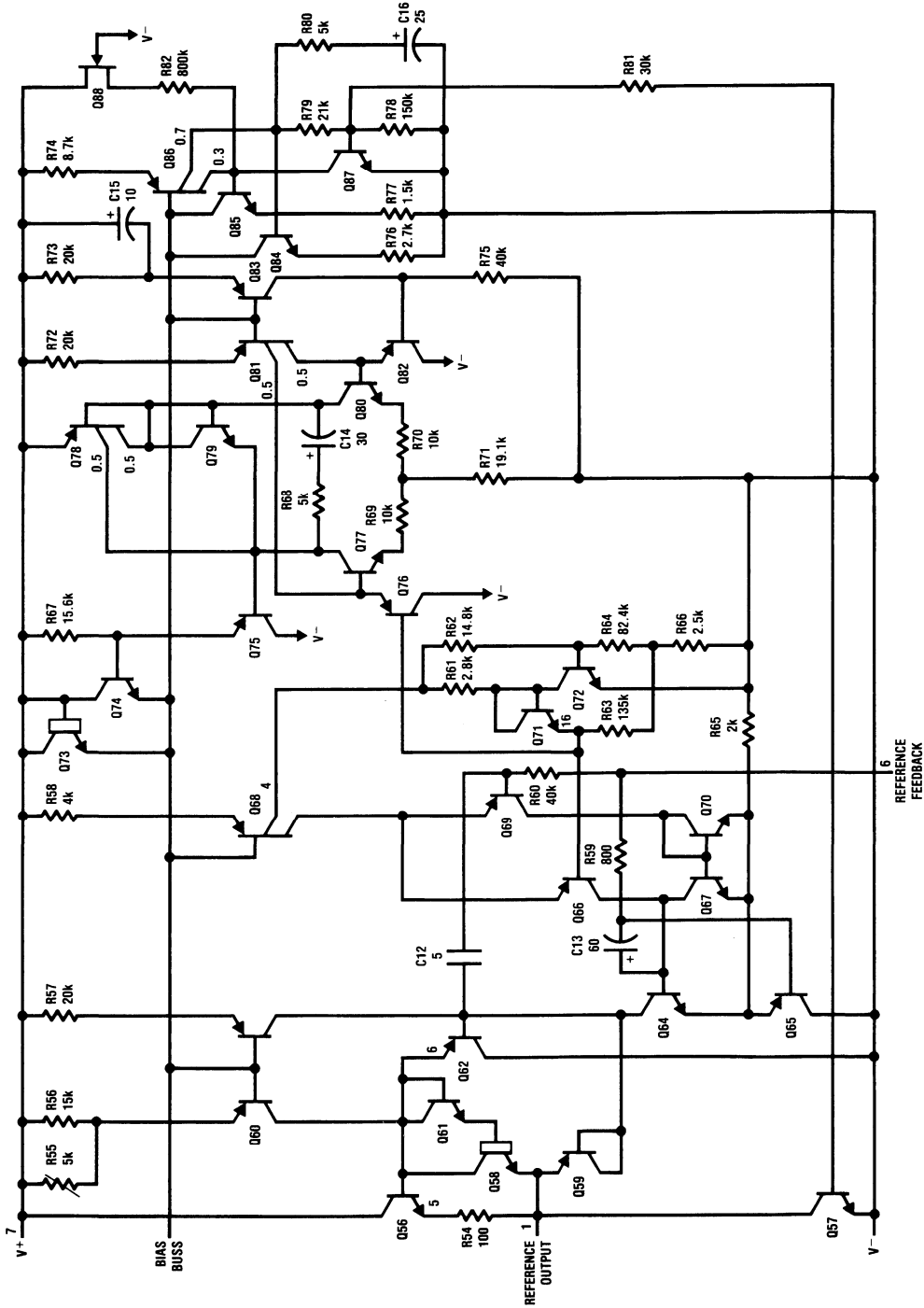


Figure 8. Complete schematic of the reference and internal regulators

Regulation is obtained with another feedback amplifier that maintains the output current of one of the current sources (Q83) at a level where the voltage drop across R75 is equal to the basic reference voltage. The differential input stage (Q77-Q80) is buffered by vertical PNPs (Q76-Q82) more for DC level shift than increased current gain. Q78 serves as a current inverter, delivering a single-ended output to a compound buffer (Q74-Q75) that drives the bias bus. The only unusual feature is Q73. It is a transistor formed using the isolation diffusion as the base. This makes the intrinsic emitter-base voltage more than 100 mV higher than a standard NPN. With this high emitter-base voltage, it can be used as a clamp on the bias bus, limiting peak current-source current under transient conditions.

A high sensitivity start-up circuit is used that will activate on leakage currents alone (Q85-Q86). However, worst-case analysis of any start up based on leakage currents, especially at low temperatures and low voltages, becomes an exercise in the unknown.

To avoid these obscure problems, a collector FET and implant resistor (Q88-R82) have been added to insure reliable operation. Once the circuit is going, Q87 disconnects the start-up circuitry, leaving Q84 to supply current to the bias bus.

performance

The characteristics of the op amp are outlined in Table I. The standard specifications compare favorably with the best of the bipolar ICs available today. The output-voltage swing, output-saturation voltage, output current, common-mode range and supply-voltage range are indeed unusual. These are indicated by the measurement conditions of relevant parameters.

Table I. Typical performance of the operation amplifier at 25°C

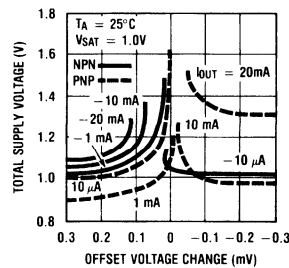
Parameter	Conditions	Value
Input Offset Voltage		0.3 mV
Offset Voltage Drift	$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	$2 \mu\text{V}/^{\circ}\text{C}$
Input Offset Current		0.25 nA
Offset Current Drift	$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	$2 \text{ pA}/^{\circ}\text{C}$
Input Bias Current		10 nA
Bias Current Drift	$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	$60 \text{ pA}/^{\circ}\text{C}$
Common-Mode Rejection	$V^- \leq V_{\text{CM}} \leq V^+ - 0.85\text{V}$	102 dB
Supply-Voltage Rejection	$1.2\text{V} \leq V_S \leq 40\text{V}$	96 dB
Unloaded Voltage Gain	$V_S = \pm 20\text{V}$, $V_O = \pm 19.97\text{V}$, $I_O = 0$	$400\text{V}/\text{mV}$
Loaded Voltage Gain	$V_S = \pm 20\text{V}$, $V_O = \pm 19.6\text{V}$, $R_L = 980\Omega$	$130\text{V}/\text{mV}$
Unity-Gain Bandwidth	$1.2\text{V} \leq V_S \leq 40\text{V}$	0.2 MHz
Slew Rate	$1.2\text{V} \leq V_S \leq 40\text{V}$	$0.15\text{V}/\mu\text{s}$

The typical specifications of the reference are given in Table II. Again it is clear that performance has not been sacrificed to realize low-voltage operation.

Table II. Typical Performance of the Reference at 25°C

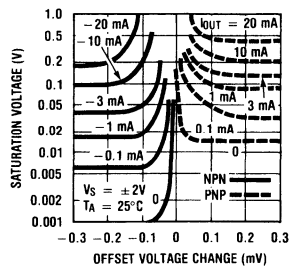
Parameter	Conditions	Value
Line Regulation	$1.2\text{V} \leq V_S \leq 40\text{V}$	0.001 %/V
Load Regulation	$0 \leq I_O \leq 1\text{ mA}$	0.01%
Feedback Sense Voltage		200 mV
Temperature Drift	$-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$	$0.002\%/^{\circ}\text{C}$
Feedback Bias Current		20 nA
Amplifier Gain	$0.2\text{V} \leq V_O \leq 75\text{V}$	$75 \text{ V}/\text{mV}$
Total Supply Current	$1.2\text{V} \leq V_S \leq 40\text{V}$	$270 \mu\text{A}$

Minimum operating voltage for the op amp depends on load current and allowable gain error as indicated in Figure 9. The typical saturation voltage of the output stage is shown in Figure 10. The voltage required to power the reference is plotted in Figure 11.



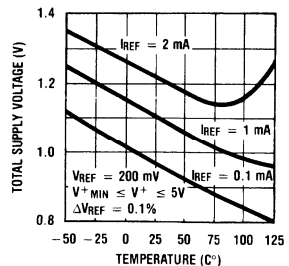
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Figure 9. Plot defining minimum supply voltage for the op amp at various load currents



TL/H/8723-10

Figure 10. Saturation characteristics of the op amp



TL/H/8723-11

Figure 11. Minimum supply voltage of the reference as a function of temperature

The total supply current for the complete IC is typically 270 μA . This is impressive only considering the performance and complexity of the circuit. This current might be reduced by a factor of 4, at the expense of speed, by raising the sheet resistance of the implanted resistors.

general

Except for the inclusion of implanted resistors, processing is essentially the same as that developed in 1968 for the LM101A. The high sheet resistivities obtained with implanted resistors strongly recommend them for micropower devices, especially at high levels of complexity. But implanted resistors have a lower breakdown voltage than their diffused counterparts (40V vs 100V). This is caused by the reduced radius of curvature at the junction edges. With higher sheet resistivities, a significant voltage coefficient of resistivity will be observed (resulting in a carrier depletion of about 10^{12} cm^{-2} at the V_{CEO} of the NPN transistors). These factors recommended that caution be used when operating implant resistors at higher voltages or that they be operated at low voltages where possible. In the circuit under discussion, none of the implant-resistor junctions see the full supply voltage.

A consequence of this low voltage design is that most of the low-level circuitry is operating at junction biases of little more than a diode drop. At this voltage, junctions are not greatly affected by minor defects. Further, in this circuit, most areas that see full supply voltage can tolerate several microamperes of leakage before operation is affected in the least. This can be expected to increase both reliability and manufacturing yield. The overall yield will also be improved because there is a substantial market for devices that will work only at low voltages.

The complete IC is built on a 97 x 105 mil die, shown in Figure 12. This is definitely large for an op amp, even when combined with a reference. But with 3-inch wafers and modern processing, die size is not the prime determinant of selling price, as long as reasonable yields are maintained. This is evidenced by the low cost of regulators having equal die area and encapsulated in more expensive power packages.

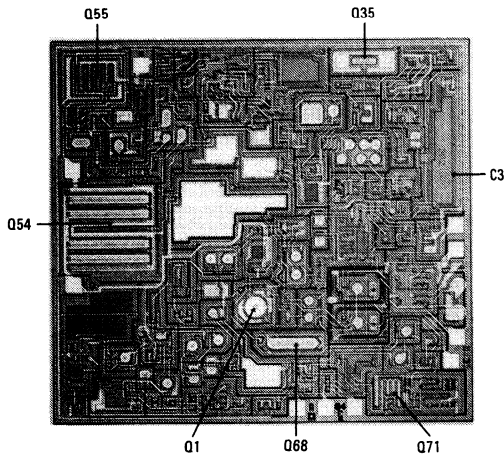


Figure 12. Photomicrograph of the IC

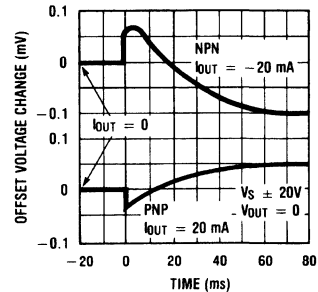
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As can be seen from Figure 12, the input-stage current-source, Q1, has been made with about 3 times the base width of the other current-source transistors. This serves both to give it the same emitter-base voltage at roughly half the current density and to make it less sensitive to changes in collector-base voltage. The latter contributes directly to improved common-mode rejection.

To save space, several lateral PNP current-sources have been built with a combination of linear emitter and emitter on a radius. Q68 in Figure 12 is an example of this. The current density at circular emitters is higher than linear emitters for a given bias voltage. This must be accounted for in design.

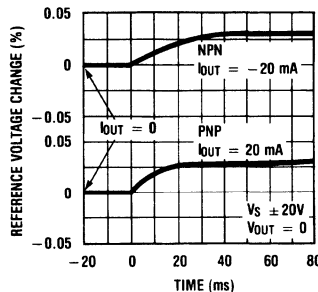
As mentioned earlier, operating biases in several places are determined by the difference in the emitter-base voltage between NPN and PNP transistors. Hence, a knowledge of these differences is essential to avoid production problems.

Since the output transistors of the op amp can dissipate considerable power, thermal gradients are potentially a problem. The effects of this dissipation have been measured and the results plotted in Figure 13. It is evident that the thermal gradients are well in hand even with 400 mW dissipation. The thermal gradient feed-through into the reference is also plotted in Figure 14. Clearly it will be insignificant at the power levels encountered in practical designs. Thermal gradient isolation is primarily the result of careful layout, since many points within the circuit are sensitive. The difficulties are, of course, mitigated by the large die size.



TL/H/8723-13

Figure 13. Effect of a pulsed load on the offset voltage of the op amp showing electrical change and that caused by thermal gradients



TL/H/8723-14

Figure 14. Cross-coupling from the op amp to the reference caused by thermal gradients

applications

There are many obvious uses for precision functions such as op amps, voltage comparators and voltage references that are capable of operating at low voltages with a small power drain. These include a variety of portable instruments, remote telemetry and even implanted medical devices.

With this battery powered equipment, there is a decided advantage in reducing operating voltage to that of a single cell. The power source will be more simple, less costly and have a higher energy content for a given size and weight. In many respects, current requirements for a given application do not decrease linearly with available supply voltage, giving an even greater advantage to single-cell operation. The resulting increase in the capacity of the power source coupled with the low drain of the electronics could eliminate the need for ON/OFF switches in certain applications.

The control circuits described earlier (*Figures 2 and 3*) that operate from residual voltages independent of fixed supplies suggest an entirely new range of equipment-design possibilities, even with line-operated power supplies. In general, the usefulness of this approach suffers greatly if minimum operating voltage is much above a volt. Low idling current is also an important consideration.

It is difficult to evaluate the impact of these new approaches mainly because they seem to represent a step change in how things can be done at the equipment-design level. But considering that low-voltage operation can be realized with no sacrifice in performance, it would seem that there are few restraints on investigating the new methods.

As a practical matter, the IC described here can also be used in a variety of ordinary applications providing significant performance advantages when compared to existing ICs. Because of this they might be expected to become an "industry standard". This is important considering the volume-related economies that strongly influence pricing in the semiconductor business. The general availability of the part can be expected to have a strong influence on the investigation of the new design methods advocated here and elsewhere.¹

conclusions

It has been shown here that high-performance linear circuits can be designed to operate with little more than a volt of supply voltage. This precludes many standard design methods that require more than two diode drops of bias. Notable among these is the Darlington connection. Alternate techniques can result in a significant increase in complexity. However, this is not a serious problem with modern manufacturing methods, providing that reasonable yield can be maintained.

Although the 270 μ A power drain of the example used is not overly impressive in the realm of micropower, it should be remembered that it is a fairly complex function designed for -55°C to $+125^{\circ}\text{C}$ operation and capable of delivering more than 20 mA of output current. A more specialized device could be built with less than a tenth the drain, especially if the maximum operating temperature could be restricted to 85°C . At elevated temperatures and low currents, the emitter-base voltage of a transistor approaches the saturation offset voltage, creating circuit problems.

In general, feedback amplifiers with more complicated signal paths become more difficult to frequency compensate. The benefits to be gained (i.e., saturating outputs and extended common-mode range) are probably justified only in low-voltage circuits. The isolation-wall capacitors introduced here ease the compensation problem some. A typical integrated circuit (LM108) has over 1000 pF of this capacitance available with no area penalty. Nonetheless, stabilizing some designs requires perseverance.

acknowledgement

Special thanks are due to Mineo Yamatake and Bob Dobkin at National Semiconductor Corporation for invaluable assistance in frequency compensating the op amp and other contributions to the final design.

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Super Matched Bipolar Transistor Pair Sets New Standards for Drift and Noise

National Semiconductor
Application Note 222



Matched bipolar transistor pairs are a very powerful design tool, yet have received less and less attention over the last few years. This is primarily due to the proliferation of high-performance monolithic circuits which are replacing many designs previously implemented with discrete components. State-of-the-art circuitry, however, is still the realm of the discrete component, especially because of recent improvements in the components themselves.

It has become clear in the past few years that ultimate performance in monolithic transistor pairs was being limited by statistical fluctuations in the material itself and in the processing environment. This led to a matched transistor pair fabricated from many different individual transistors physically located in a manner which tended to average out any residual process or material gradients. At the same time, the large number of parallel devices would reduce random fluctuations by the square root of the number of devices.

The LM194 is the end result. It is a monolithic bipolar matched transistor pair which offers an order-of-magnitude improvement in matching properties and parasitic base and emitter resistance over conventional transistor pairs. This was accomplished without compromising breakdown voltage or current gain. The LM194 is specified at 40V minimum collector-to-emitter breakdown voltage and has a minimum h_{FE} of 500 at 1 mA collector current. Maximum offset voltage is 50 μ V over a collector current range of 1 μ A to 1 mA. Maximum h_{FE} mismatch is 2%. Common mode rejection of offset voltage (dV_{OS}/dV_{CB}) is 124 dB minimum. An added benefit of paralleling many transistors is the resultant drop in overall r_{bb} and r_{ee} , which are 40 Ω and 0.4 Ω respectively. This makes the logarithmic conformity of emitter-base voltage to collector current excellent even at higher current levels where other devices become non-theoretical. In addition, broadband noise is extremely low, especially at higher operating currents.

The key to the success of the LM194 is the nearly one-to-one correlation between measured parameters and those predicted by a theoretical bipolar transistor model. The relationship between emitter-base voltage and collector current, for instance, is perfectly logarithmic over an extremely wide range of collector currents, deviating in the pA range because of leakage currents and above several milliamperes due to the finite 0.4 Ω emitter resistance. This gives the LM194 a distinct advantage in non-linear designs where true logarithmic behavior is essential to circuit accuracy. Of equal importance is the absolute nature of the logarithmic constant, both between the two halves of the device and from unit to unit. The relationship can be expressed as:

$$V_{BE1} - V_{BE2} = \frac{kT}{q} \ln \left(\frac{I_{C1}}{I_{C2}} \right)$$

This relationship holds true both within a single transistor where I_{C1} and I_{C2} represent two different operating currents and between the two halves of the LM194 where collector currents are unbalanced. Of particular importance is the fact that the kT/q logarithmic constant is an absolute quantity

dependent only on Boltzman's constant (k), absolute temperature (T), and the charge on the electron (q). Since these values are independent of processing, there is virtually no variation from unit to unit at a fixed temperature. Lab measurements indicate that the logarithmic constant measured at a 10:1 collector current ratio does not vary more than $\pm 0.5\%$ from its theoretical value. Applications such as logarithmic converters, multipliers, thermometers, voltage references, and voltage-controlled amplifiers can take advantage of this inherent accuracy to provide adjustment-free precision circuits.

APPROACHING THEORETICAL NOISE

In many low-level amplifier applications, the limiting factor on performance is noise. With bipolar transistors, the theoretical value for emitter-base voltage noise is a function only of absolute temperature and collector current.

$$e_n = kT \sqrt{\frac{2}{qI_C}} \quad \text{Volts}/\sqrt{\text{Hz}}$$

This formula indicates that voltage noise can be reduced to low levels by simply raising collector current. In fact, that is exactly what happens until collector current reaches a level where parasitic transistor noise limits any further reduction. This "noise floor" is usually created by and modeled as an equivalent resistor (r_{bb}') in series with the base of the transistor. Low parasitic base resistance is therefore an important factor in ultra-low-noise applications where collector current is pushed to the limits. The 40 Ω equivalent r_{bb}' of the LM194 is considerably lower than that of other small-signal transistors. In addition, this device has no excess noise at lower current levels and coincides almost exactly with the predicted values. A low-noise design can be done on paper with a minimum of bench testing.

Another noise component in bipolar transistors is base current noise. For any finite source impedance, current noise must be considered as a quadrature addition to voltage noise.

$$\text{total equivalent input voltage noise} = e_n = \sqrt{e_n^2 + (i_n \cdot r_s)^2} \text{Volts}/\sqrt{\text{Hz}}$$

where r_s is the source impedance

In the LM194, base current noise is a well-defined function of collector current and can be expressed as:

$$i_n = \sqrt{\frac{2q \cdot I_C}{h_{FE}}} \quad \text{Amps}/\sqrt{\text{Hz}}$$

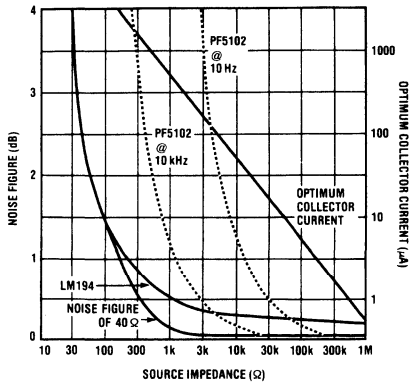
To find the collector current which yields the minimum overall equivalent input noise with a given source impedance, the total noise formula can be differentiated with respect to I_C and set equal to zero for finding a minimum.

$$\begin{aligned} e_n^2 &= e_n^2 + (i_n^2 \cdot r_s^2) + 4kT \cdot r_s \\ &= \frac{2k^2 \cdot T^2}{q \cdot I_C} + \frac{2q \cdot I_C \cdot r_s^2}{h_{FE}} + 4kT \cdot r_s \end{aligned}$$

$$\frac{d(V_N^2)}{d(I_C)} = \frac{-2k^2 \cdot T^2}{q \cdot I_C^2} + \frac{2q \cdot r_s^2}{h_{FE}} = 0$$

$$I_C (\text{optimum}) = \frac{kT}{q} \cdot \frac{\sqrt{h_{FE}}}{r_s}$$

For very low source impedances, the $40\Omega r_{bb'}$ of the LM194 should be added to r_s in this calculation. A plot of noise figure versus collector current (see curve) shows that the formula does indeed predict the optimum value. The curves are very shallow, however, and actual current can be varied by 3:1 without losing more than 1 dB noise figure in most cases. This may be a worthwhile tradeoff if low bias current ($I_C < I_{opt}$) or wide bandwidth ($I_C > I_{opt}$) is also important. Figure 1 is a plot of best obtainable noise figure versus



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FIGURE 1. Noise Figure vs Source Impedance

source impedance for the LM194 and a very low noise junction FET (PF5102). Collector current for the LM194 is optimized for each source impedance and is also plotted on the graph using the right side scale. The PF5102 is operated at a constant 1 mA. It is obvious that the bipolar device gives significantly better noise figures for low source impedances and/or low frequencies. FETs are particularly poor at very low frequencies (< 10 Hz) and offer advantages only for very high source impedances.

REACTIVE SOURCES

Calculations may also be done to derive an optimum collector current when the signal source is reactive. In this case, upper and lower frequencies (f_H and f_L) must be specified. Also, optimum current is different for an amplifier with a summing junction input ($Z_{IN} = 0$) as compared to a high impedance input ($Z_{IN} \gg X_C, X_L$). The formulas below give optimum collector current for noise within the frequency band f_L to f_H . For audio applications, lowest "perceived" noise may be somewhat different because of the variation in sensitivity of the ear to frequencies in the audio range (Fletcher-Munson effect).

Capacitive source into high impedance:

$$I_C (\text{opt}) = \frac{kT}{q} \cdot C \cdot 2\pi \cdot \sqrt{h_{FE}} \cdot \sqrt{f_H \cdot f_L}$$

Capacitive source into summing junction:

$$I_C (\text{opt}) = \frac{kT}{q} \times \frac{\sqrt{h_{FE}}}{R_f} \times \sqrt{\frac{4\pi^2 \cdot R_f^2 \cdot C^2 (f_L^2 + f_H^2 + f_L \cdot f_H)}{3} + \frac{4\pi \cdot R_f \cdot C \cdot (f_H + f_L)}{2} + 1}$$

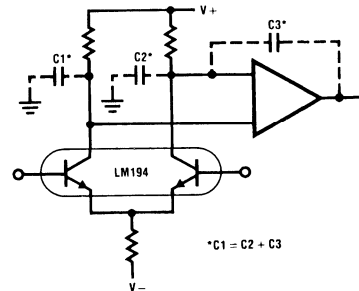
Inductive source into high impedance:

$$I_C (\text{opt}) = \frac{kT}{q} \cdot \sqrt{h_{FE}} \sqrt{\frac{3}{f_L^2 + f_H^2 + f_L \cdot f_H}}$$

Keep in mind that the simple formula for total input-referred noise, though accurate in itself, does not take into account the effects of noise created in additional stages or noise injected from supply lines. In most cases voltage gain of the LM194 stage will be sufficient to swamp out second stage effects. For this to be true, first stage gain must be at least $3 \cdot v_{n2}/v_N$, where v_{n2} is the voltage noise of the second stage and v_N is the desired total input referred voltage noise. A simple formula for voltage gain of an LM194 stage, assuming no second stage loading, is given by:

$$A_V = \frac{(R_L)(I_C)}{kT/q} \text{ where } R_L \text{ is the load resistor}$$

Noise injected from power supplies is an often overlooked problem in low noise designs. This is probably in part due to the use of IC op amps with their high power supply rejection ratio and differential inputs. Many low-noise designs are single-ended and do not enjoy the inherent supply rejection of differential designs. For a single-ended amplifier with its load resistor tied directly to the power supply, noise on the supply must be no higher than $(R_L \cdot I_C \cdot v_N)/(3 kT/q)$ or noise performance will be degraded. For a differential stage (see Figure 2) with the common emitter resistor tied to the negative supply and the collector resistors tied to the positive supply, supply noise is not generally a problem, at least at low frequencies. For this to be true at higher frequencies, the capacitance at the collector nodes must be kept low and balanced. In an unbalanced situation, noise from either supply will feed through unattenuated at higher frequencies where the reactance of the capacitor is much lower than the collector resistance.



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FIGURE 2. High Frequency Power Supply Rejection

BANDWIDTH CONSIDERATIONS

Because of its large area, the LM194 has capacitance-limited bandwidth. The $h_{fe} \cdot f$ product is roughly 0.08 MHz per microampere of collector current, yielding an f_t of 80 MHz at $I_C = 1$ mA and 800 kHz at $I_C = 10 \mu\text{A}$.

Collector-base capacitance on the LM194 is somewhat higher than ordinary small-signal transistors due to the large device geometry. C_{ob} is 17 pF at $V_{CE} = 5V$. For high gain stages with finite source impedance, the Millering effect of C_{ob} will usually be the limiting factor on voltage gain band-

width. At $I_C = 100 \mu A$ and $R_L = 50 k\Omega$, for instance, DC voltage gain will be $(R_L/I_C)/(kT/q) = 200$, but bandwidth will be limited to

$$BW = \frac{kT/q}{(2\pi)(R_L)(I_C)(R_S)(C_{ob})} = 50 \text{ kHz}$$

for a source impedance (R_S) of 1 k Ω .

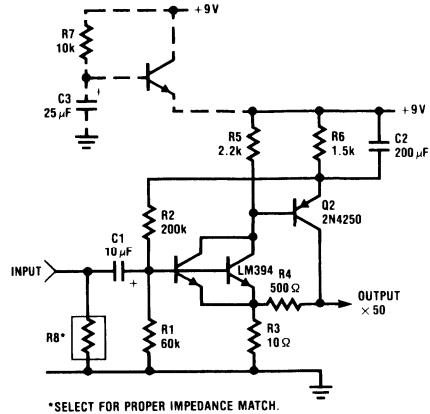
LOW NOISE APPLICATIONS

Figures 3 and 4 represent two different approaches to low noise designs. In Figure 3, the LM194 is used to replace the input stage of an LM118 high speed operational amplifier to create an ultra-low-distortion, low-noise RIAA-equalized phono preamplifier. The internal input stage of the LM118 is shut off by tying the unused inputs to the negative supply. This allows the LM194 to be used in place of the internal input stage, avoiding the loop stability problems created when extra stages are added. The stability problem is especially critical in an RIAA circuit where 100% feedback is used at high frequencies. Performance of this circuit exceeds the ability of most test equipment to measure it. As shown in the accompanying chart, Figure 3, harmonic distortion is below the measurable 0.002% level over most of the operating frequency and amplitude range. Noise referred to a 10 mV input signal is 90 dB down, measuring 0.55 μV_{RMS} and 70 pA $_{RMS}$ in a 20 kHz bandwidth. More importantly, the noise figure is less than 2 dB when the amplifier is used with standard phono cartridges, which have an equivalent wideband (20 kHz) noise of 0.7 μV^1 . Further improvements in amplifier noise characteristics would be of little use because of the noise generated by the cartridge itself.

A special test was performed to check for "Transient Intermodulation Distortion". 10 kHz and 11 kHz were mixed 1:1 at the input to give an RMS output voltage of 2V (input = 200 mV). The resulting 1 kHz intermodulation product measured at the output was 80 μV . This calculates to 0.004% distortion, an incredibly low level considering that the 1 kHz has 14 dB (5:1) gain with respect to the 10 kHz signal in an RIAA circuit. Of special interest also is the use of all DC coupling. This eliminates the overload recovery problems associated with coupling and bypass capacitors. Worst case

FREQUENCY (Hz)	TOTAL HARMONIC DISTORTION				
	<0.002	<0.002	<0.002	<0.002	<0.002
20	<0.002	<0.002	<0.002	<0.002	<0.002
100	<0.002	<0.002	<0.002	<0.002	<0.002
1k	<0.002	<0.002	<0.002	<0.002	<0.002
10k	<0.002	<0.002	<0.002	0.0025	<0.003
20k	<0.002	<0.002	0.004	0.004	0.007
	0.03	0.1	0.3	1.0	5.0

OUTPUT AMPLITUDE (V) RMS
FIGURE 3. Ultra Low Noise RIAA Phono Preamplifier



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FIGURE 4. Ultra Low Noise Preamplifier

DC output offset voltage is about 1V with a cartridge having 1 k Ω DC resistance.

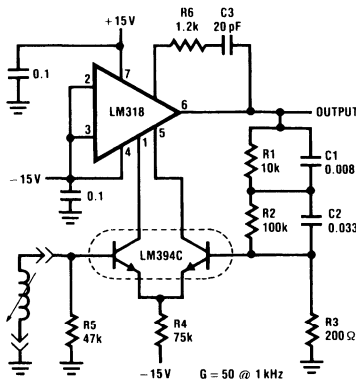
The single-ended amplifier shown in Figure 4 was designed for source impedances below 250 Ω . At this level, the LM194 should be biased at 2.5 mA (or higher) collector current. Unfortunately, $r_{bb'}$, even at 40 Ω , is the limiting factor on noise at these current levels. To achieve better performance, the two halves of the LM194 are paralleled to reduce $r_{bb'}$ to 20 Ω . Total input voltage noise for this design is given by:

$$e_N = \sqrt{4kT(r_{bb'} + R_3) + e_n^2} = \sqrt{0.504 + 0.096} = 0.775 \text{ nV}/\sqrt{\text{Hz}}$$

The current noise is 1.2 pA/ $\sqrt{\text{Hz}}$, and when this flows through a 250 Ω source resistance, it causes an additional 0.30 nV/ $\sqrt{\text{Hz}}$. Since the Johnson noise of a 250 Ω resistor is 2.0 nV/ $\sqrt{\text{Hz}}$, the noise figure is:

$$NF = 20 \log \frac{\sqrt{(2 \text{ nV})^2 + (0.3 \text{ nV})^2 + (0.775 \text{ nV})^2}}{2 \text{ nV}} = 0.74 \text{ dB}$$

Several unique features of this circuit should be pointed out. First, it has only one internal capacitor which functions as an AC bypass for both stages. Second, no input stage load resistor bypassing is used, yet the circuit achieves 56 dB supply rejection referred to input. The optional supply filter shown in dotted lines improves this by an additional 50 dB and is necessary only if supply noise exceeds 20 nV/ $\sqrt{\text{Hz}}$. Finally, the problem of AC coupling the 10 Ω feedback impedance is eliminated by using a DC biasing scheme which biases both stages simultaneously without relying on feedback from the output.



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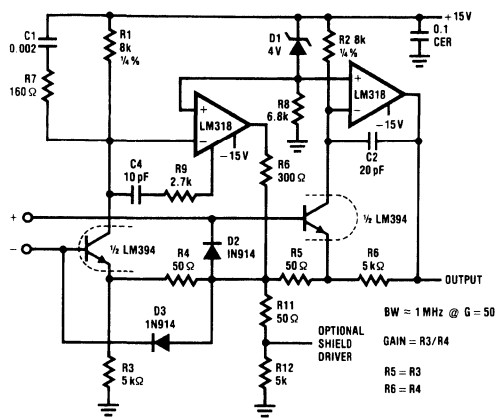
NOTE: Cartridge is assumed to have less than 5 k Ω DC resistance. Do not capacitor couple the cartridge. R1, R2, and R3 should be low noise metal film resistors.

Harmonic distortion is very low for a "simple" two stage design. At 300 mV output, total harmonic distortion measured 0.016%. For normal signal levels of 50 mV and below, distortion was lost in the noise floor. Small-signal bandwidth is 3 MHz.

An ideal application for this amplifier is as a head pre-amp for moving-coil phono cartridges. These cartridges have very low output impedance (< 50Ω at low frequencies) and have a full-output signal below 1 mV. Obviously, the preamp used for such a low signal level must have superb noise properties. The amplifier shown has a total RMS input noise of 0.11 μV in a 20 kHz bandwidth, yielding a signal-to-noise ratio of 70 dB when used with a 40Ω source impedance at a 0.5 mV signal level.

LOW-NOISE, LOW-DRIFT INSTRUMENTATION AMPLIFIER HAS WIDE BANDWIDTH

The circuit in Figure 5 is a high-performance instrumentation amplifier for low-noise, low-drift, wide-bandwidth applications. Input noise voltage is 2 nV/√Hz up to 20 kHz, rising



TL/L/6922-5

FIGURE 5. Low Drift-Low Noise Instrumentation Amplifier

to 3.5 nV/√Hz at 100 kHz. Bandwidth at a gain of 50 is 1 MHz and gain can be varied over the range of 10–100 simply by changing the value of R₃ and R₆. Input offset voltage drift is determined by the LM194 and the tracking of the (R₁–R₂), (R₃–R₆), and (R₄–R₅) pairs. 20 ppm/°C mismatch on all pairs will generate 1.1 μV/°C referred to input, dominating the drift due to the LM194. Resistor pairs which track to 5 ppm/°C or better are recommended for very low drift applications. Input bias current is about 1 μA, rather high for general purpose use, but necessary in this case to achieve wide bandwidth and low noise. The tight matching of the LM194, however, reduces input offset current to 20 nA, and input offset current drift to 0.5 nA/°C. Input bias current drift is under 10 nA/°C. In terms of source impedance, total input referred voltage drift will be degraded 1 μV/°C for each 100Ω of unbalanced source resistance and 0.05 μV/°C for each 100Ω of balanced source resistance. DC common mode rejection of this amplifier is extremely good, depending mostly on the match of the ratio of R₃/R₄ to R₅/R₆. 0.1% matching gives better than 90 dB. Rejection will improve with tighter matching and is not limited by the LM194 until CMRR approaches 120 dB. High frequency CMRR is also very good, measuring 80 dB at 20 kHz and 60 dB at 100 kHz. Settling time for a 10V output step is

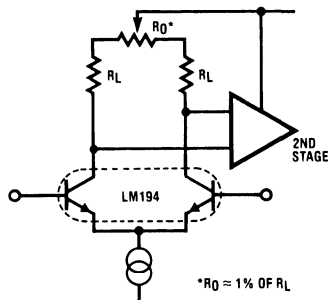
1.5 μs to 0.1%, and 5 μs to 0.01%. Distortion with 10 V_{p-p} output is virtually unmeasurable (< 0.002%) at low frequencies, rising to 0.1% at 50 kHz, and 1% at 200 kHz.

LOW DRIFT DESIGNS

Offset voltage drive in the LM194 quite closely follows the theoretical value derived by differentiating the logarithmic formula. In other words it is a function only of the original offset voltage. If V_{OS} is the original room temperature offset voltage, drift of offset as given by differentiation yields:

$$\begin{aligned} \frac{d(V_{OS})}{dT} &= \frac{\left(d kT/q \ln \frac{V_{OS}}{e^{kT/q}} \right)}{dT} \\ &= \frac{V_{OS}}{T} \end{aligned}$$

At room temperature (T = 297°K), 1 mV of offset voltage will generate 1 mV/297°K = 3.37 μV/°C drift. The LM194 with a maximum offset voltage of 50 μV could be expected to have a maximum offset voltage drift of 0.17 μV/°C. Lab measurements indicate that it does not deviate from this theoretical drift by more than 0.1 μV/°C. This means the LM194 can be specified at 0.3 μV/°C drift without an individual drift test on each device. In addition, if initial offset voltage is zeroed out, maximum drift will be less than 0.1 μV/°C. The zeroing, of course, must be done in a way that theoretically zeroes drift. This is best done as shown in Figure 6 with a small trimpot used to unbalance collector load resistors. (See National's Application Note AN-3.)



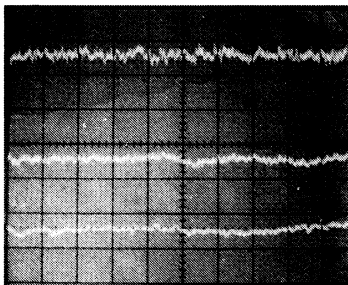
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FIGURE 6. Zeroing Offset and Drift

To obtain optimum performance from such a low-drift device, strict attention must be paid to sources of drift external to the device itself. These include thermocouple effects, mismatch in load-resistor temperature coefficients, second-stage loading, collector leakage, and finite source impedance.

Thermocouple effects in ultra-low-drift amplifiers are often the limiting factor in performance. The copper-to-Kovar (LM194 leads) thermocouple will generate 35 μV/°C. This sounds extremely high, but is not a problem if all input leads on the LM194 are at the same temperature. For optimum drift performance, the differential lead temperature where copper connects to Kovar should not exceed 0.5 millidegrees per degree change in ambient. If the LM194 is mounted on a printed circuit board, emitter and base leads should be soldered to identical size pads and the package orientation should place emitter and base leads on isothermal lines if any significant power is being dissipated on the board. The board should be kept in a still-air environment to minimize the effects of circulating air currents. "Still" air is particularly important when the LM194 leads are soldered di-

rectly to wires and when low (< 10 Hz) noise is critical. Individual wires in air can easily generate a differential end temperature of 10 millidegrees in an ordinary room ambient, even with the wires twisted together. This can cause up to $1 \mu\text{V}_{\text{p-p}}$ fluctuation in offset voltage. The 0.001 Hz to 10 Hz noise of the LM194 operating differentially at $100 \mu\text{A}$ is typically $40 \text{ nV}_{\text{p-p}}$ (see Figure 7), so the thermally generated signal represents a 25:1 degradation of low frequency noise.



TL/L/6922-7

FIGURE 7. Low Frequency Noise of Differential Pair.
Unit must be in still air environment so that differential lead temperature is held to less than 0.0003°C .

If the load resistors used to bias the LM194 do not have identical temperature coefficients, they will contribute to offset voltage drift. A $1 \text{ ppm}/^\circ\text{C}$ mismatch in resistor drift will generate $0.026 \mu\text{V}/^\circ\text{C}$ drift in the LM194. Resistors with $10 \text{ ppm}/^\circ\text{C}$ differential drift will seriously degrade the drift of an otherwise perfect circuit design. Resistors specified to track better than $2 \text{ ppm}/^\circ\text{C}$ are available from several manufacturers including Vishay, Julie, RCL, TRW, and Tel Labs.

Source impedance must be considered in a low-drift amplifier since voltage drift at the output can result from drift of the base currents of the LM194. Base current changes at about $-0.8\%/^\circ\text{C}$. This is equal to $2 \text{ nA}/^\circ\text{C}$ at a collector current of $100 \mu\text{A}$ and an h_{FE} of 400. If drift error caused by the changing base current is to be kept to less than $0.05 \mu\text{V}/^\circ\text{C}$, source unbalance cannot exceed 25Ω in this example. If a balanced condition exists, source impedance is still limited by the base current mismatch of the LM194. Worst case offset in the base current is 2%, and this offset can have a temperature drift of up to $2\%/^\circ\text{C}$, yielding a change in offset current of up to

$$(2\%)(100 \mu\text{A})(2\%/^\circ\text{C})/h_{\text{FE}} = 0.1 \text{ nA}/^\circ\text{C}$$

at a collector current of $100 \mu\text{A}$. This limits balanced source impedances to 500Ω at collector currents of $100 \mu\text{A}$ if drift error is to be kept under $0.05 \mu\text{V}/^\circ\text{C}$. For higher source impedances, collector current must be reduced, or drift trimming must be used.

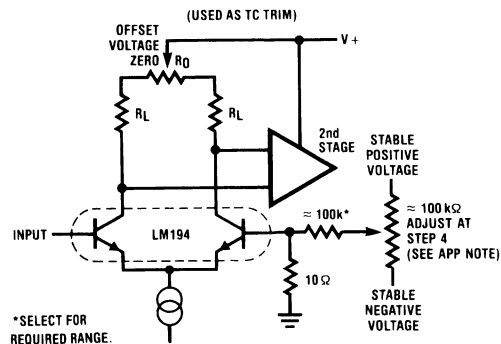
Collector-leakage effects on drift are generally very low for temperatures below 50°C . At higher temperatures, leakage can be a factor, especially at low collector currents. At 70°C , total collector leakage (to base and substrate) is typically 2 nA , increasing at $0.2 \text{ nA}/^\circ\text{C}$. Assuming a 10% mismatch between collector leakages, input-referred drift will be $0.05 \mu\text{V}/^\circ\text{C}$ at a collector current of $10 \mu\text{A}$, and $0.005 \mu\text{V}/^\circ\text{C}$ at $100 \mu\text{A}$. At 125°C , input referred drift will be $1.5 \mu\text{V}/^\circ\text{C}$ and $0.15 \mu\text{V}/^\circ\text{C}$ respectively.

The amplifier used in conjunction with the LM194 may contribute significantly to drift if its own drift characteristics are poor. An LM194 operated with $2.5 V_{\text{DC}}$ across its load resistors has a voltage gain of approximately 100. If the second stage amplifier has a voltage drift of $20 \mu\text{V}/^\circ\text{C}$ (normal for an amplifier with $V_{\text{OS}} = 6 \text{ mV}$) the drift referred to the LM194 inputs will be $0.2 \mu\text{V}/^\circ\text{C}$, a significant degradation in drift. Amplifiers with low drift such as the LM108A or LM308A ($5 \mu\text{V}/^\circ\text{C}$ max) are recommended.

For the ultimate in low drift applications, the residual drift of the LM194 can be zeroed out. This is particularly easy because of the known relationship between a change in room-temperature offset and the resultant change in offset drift. The zeroing technique involves only one oven test to establish initial drift. The drift can then be reduced to below $0.03 \mu\text{V}/^\circ\text{C}$ with a simple room-temperature adjustment. The procedure is as follows: (See Figure 8.)

1. Zero the offset voltage at room temperature (T_A).
2. Raise oven temperature to desired level (T_H) and measure offset voltage.
3. Bring circuit back to room temperature and adjust offset voltage to $(V_{\text{OS}} \text{ at } T_H) \cdot (T_A)/(T_H - T_A)$. (T is in $^\circ\text{K}$.)
4. Re-adjust offset voltage to zero with an external reference source by summing the two signals. (Do not re-adjust the offset of the LM194.)

This technique can be extended to include drift correction for source-generated drift as well since the basic correcting mechanism is independent of the source of drift.



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FIGURE 8. Correcting for Residual or Source Generated Drift

VOLTAGE REFERENCE

Voltage references utilizing the bandgap voltage of silicon were first used 8 years ago, and have since gained wide acceptance in such circuits as the LM109, LM113, LM340, LM117, $\mu\text{A}7800$, AD580, and REF 01. The theory has been well publicized and is not reiterated here.

The circuit in Figure 9 is a micropower version of a bandgap technique first used by Analog Devices. It operates off a single 2.5V to 6V supply and draws only $25 \mu\text{A}$ idling current. Two AA penlight cells will power the reference for over a year of continuous operation. Maximum output current is 0.5 mA , with an output resistance of 0.2Ω . Line regulation is $\sim 0.01\%/V$ and output noise is $20 \mu\text{V}_{\text{RMS}}$ over a 10 kHz bandwidth. Temperature drift is less than $\pm 50 \text{ ppm}/^\circ\text{C}$ when the output is trimmed to 1.21V . Much lower drift can be obtained by adjusting the output of each reference to the

optimum value. A 1% shift in output voltage changes drift 33 ppm/°C. Temperature range is -25°C to +100°C.

The LM194 is the entire reference in this design, supplying both V_{BE} and ΔV_{BE} portions of the reference. One half LM114 delivers a constant bias current to the LM4250. The other half, in conjunction with the 2N4250 PNP, ensures startup of the circuit under worst cast (2.4k) load current. R_1 - R_2 and R_4 - R_5 should track to 50 ppm/°C. R_6 should have a TC of under 250 ppm/°C. The circuit is stable for capacitive loads up to 0.047 μ F. C_2 is optional, for improved ripple rejection.

STRAIN GAUGE AMPLIFIER

The instrumentation amplifier shown in Figure 10 is an example of an ultra-low-drift design specifically optimized for strain-gauge applications. A typical strain-gauge bridge has one end grounded and the other driven by a 3-to-10 volt precision voltage reference. The differential output signal of the bridge has a 1.5 to 5 volt common-mode level and a typical full-scale differential signal level of 5-50 mV. Source impedance is in the range of 100 Ω to 500 Ω , with an impedance imbalance of less than 2%. This amplifier has been specifically optimized for these types of signals. It has a

+1V to +10V common mode range, a full scale input of 20 mV (1 mV to 100 mV is possible) and fully balanced inputs with a differential input impedance > 10 M Ω . Common mode input impedance is 100 M Ω . Common mode rejection ratio is 120 dB at 60 Hz, 114 dB at 1 kHz, and 94 dB at 10 kHz referred to input. Power supply rejection at DC is 114 dB on the V_+ supply and 108 dB on the V_- supply. Small signal bandwidth is > 50 kHz and slew rate is 0.1 V/ μ s. Gain error is determined by the accuracy of R_9 , R_8 , R_4 , and R_3 . For the values shown, gain is 500. R_3 can be varied to set gain as desired from 250 (800 Ω) to 10,000 (20 Ω). Gain non-linearity is < 0.05% for a 10V output and < 0.012% for a 5V output). R_7 is a +0.3%/°C positive-temperature-coefficient wirewound resistor for compensation of gain with temperature. Without this resistor, gain change with temperature is 0.007%/°C. If R_7 is omitted, replace R_9 with 12.4 k Ω .

Input offset voltage drift is determined primarily by resistor mismatches between R_1/R_2 and R_5/R_6 . If either of these ratios drifts by 5 ppm/°C, an input offset voltage drift of 0.15 μ V/°C will be created. Other resistor drifts contribute to gain error only. R_{12} is used to adjust room temperature offset voltage to zero.

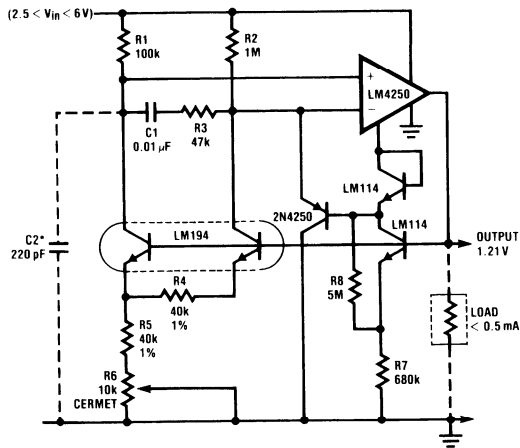


FIGURE 9. Micropower Reference

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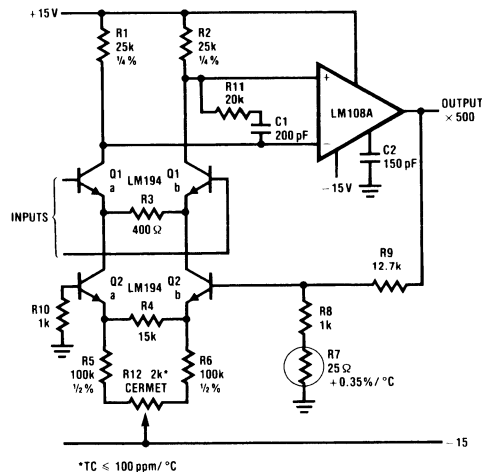


FIGURE 10. Strain Gauge Instrumentation Amplifier

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THERMOCOUPLE AMPLIFIER WITH COLD JUNCTION COMPENSATION

Thermocouple amplifiers need low offset voltage drift, good gain accuracy, low noise, and most importantly, cold-junction compensation. The amplifier in *Figure 11* does all that and more. It is specifically designed for ease of calibration so that repeated oven cycling is not required for calibration of gain and zero. Also, no mathematical calculations are required in the calibration procedure.

The circuit is basically a non-inverting amplifier with the gain set to give 10 mV/(°F or °C) at the output. This output sensitivity is arbitrary and can be set higher or lower. Cold-junction compensation is achieved by deliberately unbalancing the collector currents of the LM194 so that the resulting input offset voltage drift is just equal to the thermocouple output (α) at room temperature. By combining the formulas for offset voltage versus current imbalance and offset voltage drift, the required ratio of collector currents is obtained.

$$\frac{d(V_{OS})}{dT} = \frac{V_{OS}}{T} = \frac{k}{q} \ln \frac{I_{C1}}{I_{C2}}$$

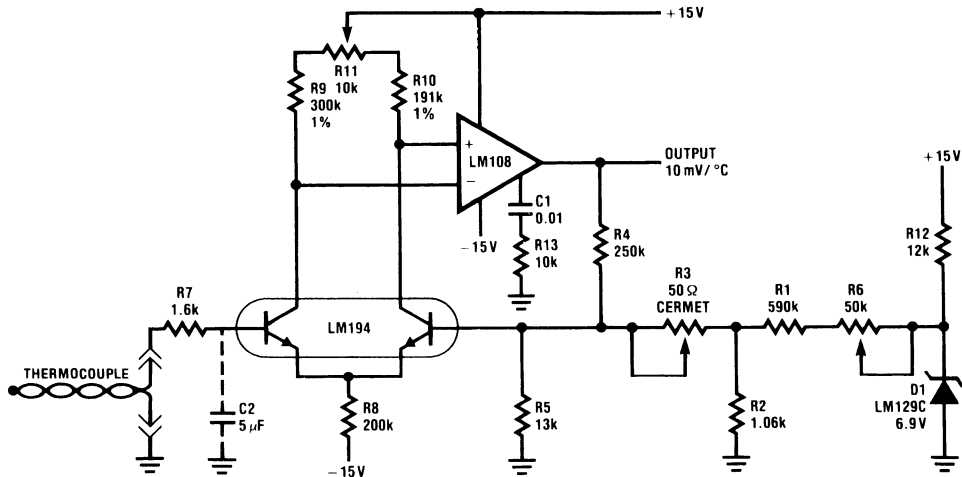
$$\ln \frac{I_{C1}}{I_{C2}} = \frac{q \cdot V_{OS}}{k \cdot T} = \frac{q \cdot \alpha}{k}$$

$$\frac{I_{C1}}{I_{C2}} = e^{\frac{q \cdot \alpha}{k}}$$

(α = thermocouple output in V/°C)

This technique does require that the LM194 be at the same temperature as the thermocouple cold junction. The thermocouple leads should be terminated close to the LM194.

The deliberate offset voltage created across the LM194 inputs must be subtracted out with an external reference which is also used to zero shift the output to read directly in °C or °F. This is done in a special way so that at some arbitrarily selected temperature (T_1), the gain adjustment has no effect on zero, vastly simplifying the calibration procedure. Design equations for the circuit are shown with the schematic in descending order of their proper use. Also shown is the calibration procedure, which requires only one oven trip for both gain and zero. Use of the nearest pocket calculator should yield all resistor values in a few minutes. The values shown on the schematic are for a 10 mV/°C output with a Chromel-Alumel thermocouple delivering 40 μ V/°C, with T_1 selected at room temperature (297°K). All resistors except R_8 and R_{12} should be 1% metal film types



TL/L/6922-11

1. Select $R_9 = 300 \text{ k}\Omega$
2. Set R_{10} equal to $R_9 \cdot e^{-\alpha(1.16 \times 10^4)}$
3. $R_8 = 200\text{k}$
4. Select R_4 in the range 50 k Ω to 250 k Ω
5. $R_5 = \frac{(R_4)(T_1)(\alpha)}{S(T_1 - T_0) - \alpha(T_1)}$
6. $R_2 = \frac{\alpha(R_4)(R_5)(1 - E/(100))}{(S - \alpha) \left[R_5 - \frac{\alpha(R_4)}{S - \alpha} \right]}$
7. $R_1 = \frac{[(R_2) \cdot V_Z - \alpha(T_1)]}{\alpha(T_1)} (0.95)$
8. $R_3 = \frac{\alpha(R_2)}{50}$
9. $R_7 = (R_9/R_{10})(R_2)$
10. $R_6 = R_1/10$

$E =$ Gain error allowed for ($\approx 2.5\%$)
 $T_1 =$ Temperature in °K at which it is desired to have the gain control not interact with the zero control
 $T_0 =$ Temperature in °K at which the desired temperature scale (°C or °F) is equal to zero
 $S =$ Required output scale factor. Use V/°C even though actual output may be in °F
 $V_Z =$ Zener reference voltage
 $\alpha =$ Thermocouple output in V/°C
 Values shown on schematic are for 10 mV/°C.
 See below for 10 mV/°F values using a Chromel-Alumel thermocouple with room temperature for T_1 .

$R_1 = 367\text{k}$, $R_2 = 629\Omega$, $R_3 = \Omega$, $R_4 = 250\text{k}$,
 $R_5 = 4.08\text{k}$, $R_6 = 50\text{k}$, $R_7 = 1\text{k}$, $R_{10} = 191\text{k}$

- CALIBRATION:***
- a. Set oven to T_1 and adjust R_6 to give proper output (zero adjust).
 - b. Raise (or lower) oven to T_2 and adjust R_3 to give proper output at T_2 (gain adjust).
 - c. Return to room temperature and short thermocouple and D1 to ground. Adjust R_{11} to give proper output (room ambient) in °K or °F. For 10 mV/°C, this is 2.98V @ $T_A = 25^\circ\text{C}$. For 10 mV/°F, this is 5.37V @ $T_A = 77^\circ\text{F}$.
 - d. Remove shorts and re-adjust R_6 if necessary to zero output.
- Note: Steps C and D can be eliminated if exact cold junction compensation is not required. R_{11} is simply shorted out. Compensation will be within $\pm 5\%$ without adjustment ($\leq 0.05^\circ\text{C}/^\circ\text{C}$).

*Thermocouple only in oven.

FIGURE 11. Thermocouple Amplifier with Cold-Junction Compensation

for low thermocouple effects (resistors *do* generate thermocouple voltages if their ends are at different temperatures) and should have low temperature coefficients. R_9 and R_{10} should track to 10 ppm/°C. R_3 , R_6 , and R_{11} should not have a TC higher than 250 ppm/°C. R_1 , R_2 , and R_4 should track to 20 ppm/°C. C_2 can be added to reduce spikes and noise from long thermocouple lines.

Input impedance for this circuit is $> 100\text{ M}\Omega$, so high thermocouple impedance will not affect scale factor. "Zero shift" due to input bias current is approximately 1°C for each 400 Ω of thermocouple lead resistance with a 40 $\mu\text{V}/^\circ\text{C}$ thermocouple.

No provision is made for correction of thermocouple non-linearity. This could be accomplished with a slight nonlinearity introduced into R_4 with additional resistors and diodes. Another possibility is to digitize the output and correct the non-linearity digitally with a ROM programmed for a specific thermocouple type.

POWER METER

The power meter in *Figure 12* is a good example of minimum-parts-count design. It uses only one transistor pair to provide the complete $(X) \cdot (Y)$ function. The circuit is intended for 117 $V_{AC} \pm 50 V_{AC}$ operation, but can be easily modified for higher or lower voltages. It measures true (non-reactive) power being delivered to the load and requires no external power supply. Idling power drain is only 0.5W. Load current sensing voltage is only 10 mV, keeping load voltage loss to 0.01%. Rejection of reactive load currents is better than 100:1 for linear loads. Nonlinearity is about 1% full scale when using a 50 μA meter movement. Temperature correction for gain is accomplished by using a copper shunt (+0.32%/°C) for load-current sensing. This circuit measures power on negative cycles only, and so cannot be used on rectifying loads.

LOW COST MATHEMATICAL FUNCTIONS

Many analog circuits require a mathematical function to be performed on one or more signals other than the standard addition, subtraction, or scaling which can be accomplished with resistor networks. The circuits shown in *Figures 13* through *15* are examples of low-cost function generating circuits using the LM394 with operational amplifiers. The logarithmic relationship of V_{BE} to I_C on the LM394 is utilized in each case to log-antilog the input signals so that addition and subtraction can be used to multiply, divide, square, etc. When transistors are used in this manner, matching is very critical. A 1 mV offset in V_{BE} appears as a 4% of signal error even in the best case where operation is restricted to one quadrant. Parasitic emitter or base resistance (r_{ee} , r_{bb}) can also seriously degrade accuracy. At $I_C = 100\ \mu\text{A}$ and $h_{FE} = 100$, each Ω of emitter resistance and each 100 Ω of base resistance will cause 0.4% signal error. Most matched transistor pairs available today have significant parasitic resistances which severely limit their use in high-accuracy circuits. The LM394, with offset guaranteed below 0.15 mV and a typical emitter-referred total parasitic resistance of 0.4 Ω gives an order of magnitude improvement in accuracy to nonlinear designs at all current levels.

MULTIPLIER/DIVIDER

The circuit in *Figure 13* will give an output proportional to the product of the (X) and (Y) inputs divided by the Z input. All inputs must be positive, limiting operation to one quadrant, but this restriction removes the large error terms found in 2- and 4-quadrant designs. In a large percentage of cases, analog signals requiring multiplication are of one polarity

only and can be inverted if negative. A nice feature of this design is that all gain errors can be trimmed to zero at one point. R_5 is paralleled with 2.4 $\text{M}\Omega$ to drop its nominal value 2%. R_8 then gives a $\pm 2\%$ gain trim to account for errors in R_1 , R_2 , R_5 , R_7 , and any offset in Q_1 or Q_2 . For very low level inputs, offset voltage in the LM308s may create large percentage errors referred to input. A simple scheme for offsetting any of the LM308s to zero is shown in dotted lined; the + input of the appropriate LM308 is simply tied to R_x instead of ground for zeroing. The summing mode of operation on all inputs allows easy scaling on any or all inputs. Simply set the input resistor equal to $(V_{IN(max)})/(200\ \mu\text{A})$. V_{OUT} is equal to:

$$V_{OUT} = \frac{\left(\frac{X}{R_1}\right) \left(\frac{Y}{R_2}\right) (R_5)}{\frac{Z}{R_7}}$$

Input voltages above the supply voltage are allowed because of the summing mode of operation. Several inputs may be summed at "X", "Y," or "Z."

Proper scaling will improve accuracy by preventing large current imbalances in Q_1 and Q_2 , and by creating the largest possible output swing. Keep in mind that any multiplier scheme must have a reference and this circuit is no different. For a simple $(X) \cdot (Y)$ or $(X)/Z$ function, the unused input must be tied to a reference voltage. Perturbations in this reference will be seen at the output as scale factor changes, so a stable reference is necessary for precision work. For less critical applications, the unused input may be tied to the positive supply voltage, with $R = V^+ / 200\ \mu\text{A}$.

SQUARE ROOT

The circuit in *Figure 14* will generate the square root function at low cost and good accuracy. The output is a current which may be used to drive a meter directly or be converted to a voltage with a summing junction current-to-voltage converter. The -15V supply is used as a reference, so it must be stable. A 1% change in the -15V supply will give a 1/2% shift in output reading. No positive supply is required when an LM301A is used because its inputs may be used at the same voltage as the positive supply (ground). The two 1N457 diodes and the 300 k Ω resistor are used to temperature compensate the current through the diode-connected 1/2 LM394.

SQUARING FUNCTION

The circuit in *Figure 15* will square the input signal and deliver the result as an output current. Full scale input is 10V, but this may be changed simply by changing the value of the 100 k Ω input resistor. As in the square root circuit, the -15V supply is used as the reference. In this case, however, a 1% shift in supply voltage gives a 1% shift in output signal. The 150 k Ω resistor across the base-emitter of 1/2 LM394 provides slight temperature compensation of the reference current from the -15V supply. For improved accuracy at low input signal levels, the offset voltage of the LM301A should be zeroed out, and a 100 k Ω resistor should be inserted in the positive input to provide optimum DC balance.

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1. See National's *Audio Handbook*.
2. *The Audio Amateur*, volume VIII, number 1, Feb. 1977.

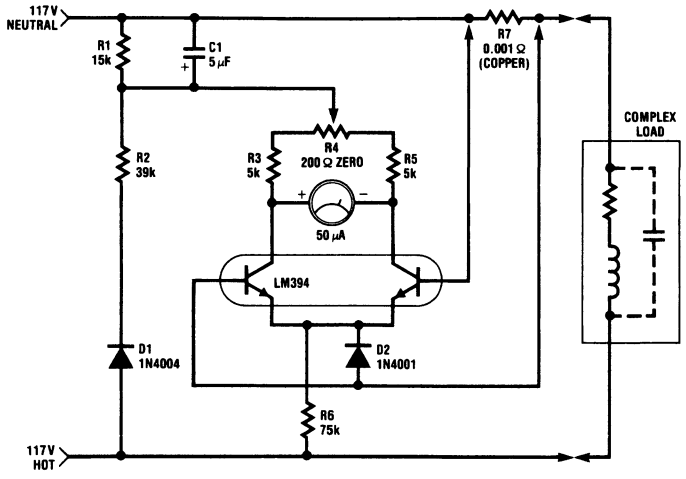
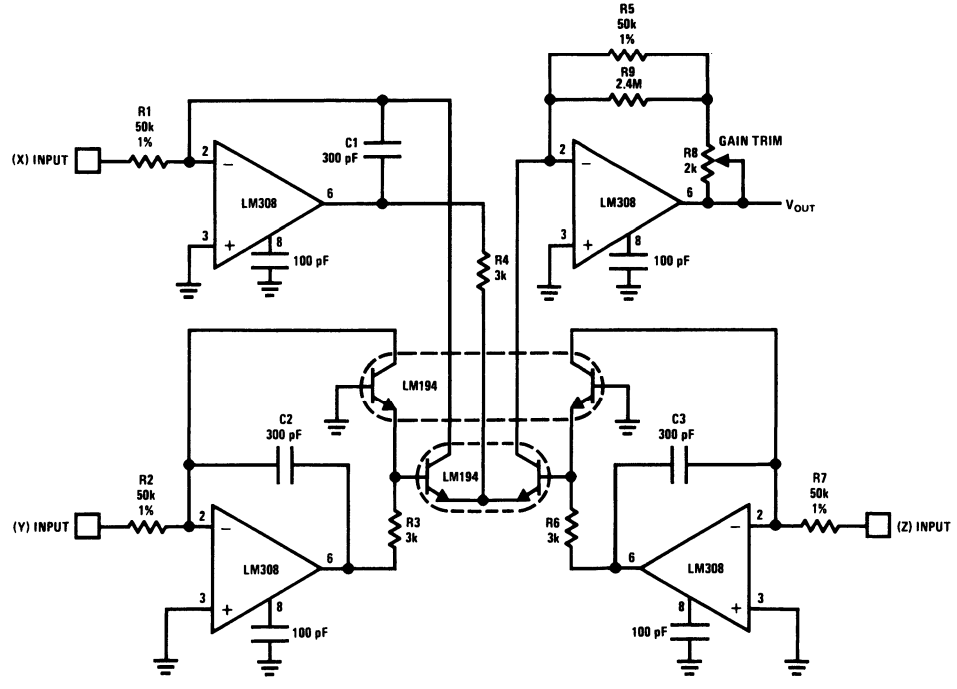
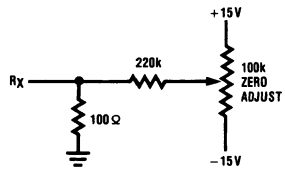


FIGURE 12. Power Meter (1 kW f.s.)

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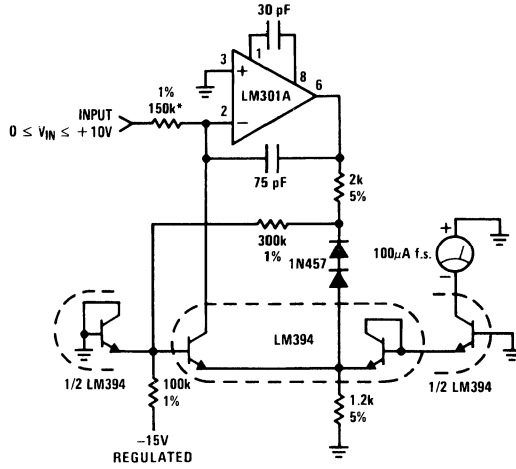


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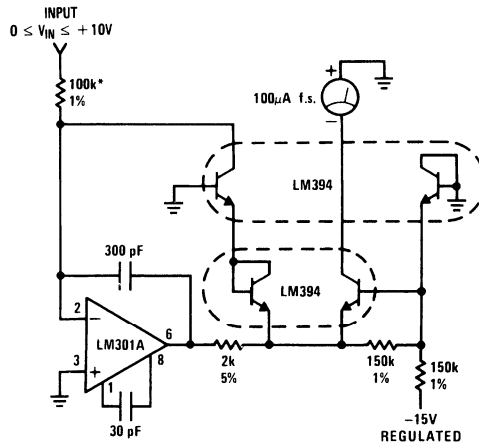
FIGURE 13. High Accuracy One Quadrant Multiplier/Divider



TL/L/6922-15

*Trim for full scale accuracy.

FIGURE 14. Low Cost Accurate Square Root Circuit
 $I_{OUT} = 10^{-5} \sqrt{10 V_{IN}}$



TL/L/6922-16

*Trim for full scale accuracy.

FIGURE 15. Low Cost Accurate Squaring Circuit
 $I_{OUT} = 10^{-6} (V_{IN})^2$

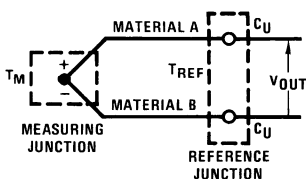
IC Temperature Sensor Provides Thermocouple Cold-Junction Compensation

National Semiconductor
Application Note 225
Michael X. Maida



INTRODUCTION

Due to their low cost and ease of use, thermocouples are still a popular means for making temperature measurements up to several thousand degrees centigrade. A thermocouple is made by joining wires of two different metals as shown in *Figure 1*. The output voltage is approximately proportional to the temperature difference between the measuring junction and the reference junction. This constant of proportionality is known as the Seebeck coefficient and ranges from $5 \mu\text{V}/^\circ\text{C}$ to $50 \mu\text{V}/^\circ\text{C}$ for commonly used thermocouples.



$$V_{OUT} \approx \alpha(T_M - T_{REF})$$

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FIGURE 1. Thermocouple

Because a thermocouple is sensitive to a temperature *difference*, the temperature at the reference junction must be known in order to make a temperature measurement. One way to do this is to keep the reference junction in an ice bath. This has the advantage of zero output voltage at 0°C , making thermocouple tables usable. A more convenient approach, known as cold-junction compensation, is to add a compensating voltage to the thermocouple output so that the reference junction appears to be at 0°C independent of the actual temperature. If this voltage is made proportional to temperature with the same constant of proportionality as the thermocouple, changes in ambient temperature will have no effect on output voltage.

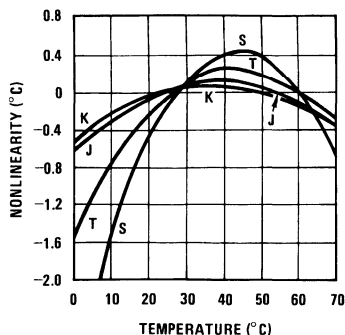
An IC temperature sensor such as the LM135/LM235/LM335, which has a very linear voltage vs. temperature characteristic, is a natural choice to use in this compensation circuit. The LM135 operates by sensing the difference of base-emitter voltage of two transistors running at different current levels and acts like a zener diode with a breakdown voltage proportional to absolute temperature at $10 \text{ mV}/^\circ\text{K}$. Furthermore, because the LM135 extrapolates to zero output at 0°K , the temperature coefficient of the compensation circuit can be adjusted at room temperature without requiring any temperature cycling.

SOURCES OF ERROR

There will be several sources of error involved when measuring temperature with thermocouples. The most basic of

these is the tolerance of the thermocouple itself, due to varying composition of the wire material. Note that this tolerance states how much the voltage vs. temperature characteristic differs from that of an ideal thermocouple and has nothing to do with nonlinearity. Tolerance is typically $\pm 3/4\%$ of reading for J, K, and T types or $\pm 1/2\%$ for S and R types, so that a measurement of 1000°C may be off by as much as 7.5°C . Special wire is available with half this error guaranteed.

Additional error can be introduced by the compensation circuitry. For perfect compensation, the compensation circuit must match the output of an ice-point-referenced thermocouple at ambient. It is difficult to match the thermocouple's nonlinear voltage vs. temperature characteristic with a linear absolute temperature sensor, so a "best fit" linear approximation must be made. In *Figure 2* this nonlinearity is plotted as a function of temperature for several thermocouple types. The K type is the most linear, while the S type is one of the least linear. When using an absolute temperature sensor for cold-junction compensation, compensation error is a function of both thermocouple nonlinearity and also the variation in ambient temperature, since the straight-line approximation to the thermocouple characteristic is more valid for small deviations.



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FIGURE 2. Thermocouple Nonlinearity

Of course, increased error results if, due to component inaccuracies, the compensation circuit does not produce the ideal output. The LM335 is very linear with respect to absolute temperature and introduces little error. However, the complete circuit must contain resistors and a voltage reference in order to obtain the proper offset and scaling. Initial tolerances can be trimmed out, but the temperature coefficient of these external components is usually the limiting factor (unless this drift is measured and trimmed out).

CIRCUIT DESCRIPTION

A single-supply circuit is shown in *Figure 3*. R3 and R4 divide down the 10 mV/°K output of the LM335 to match the Seebeck coefficient of the thermocouple. The LM329B and its associated voltage divider provide a voltage to buck out the 0°C output of the LM335. To calibrate, adjust R1 so that $V1 = \alpha T$, where α is the Seebeck coefficient* and T is the ambient temperature in degrees Kelvin. Then, adjust R2 so that $V1 - V2$ is equal to the thermocouple output voltage at the known ambient temperature.

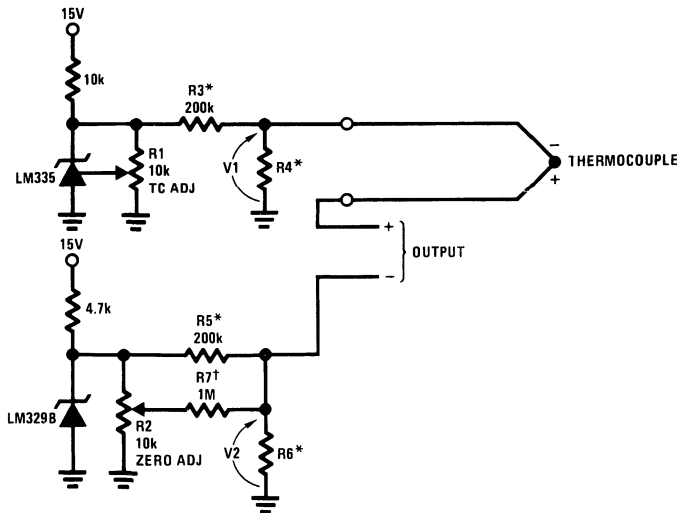
To achieve maximum performance from this circuit the resistors must be carefully chosen. R3 through R6 should be precision wirewounds, Vishay bulk metal or precision metal film types with a 1% tolerance and a temperature coefficient of ± 5 ppm/°C or better. In addition to having a low TCR, these resistors exhibit low thermal emf when the leads are at different temperatures, ranging from $3 \mu\text{V}/^\circ\text{C}$ for the TRW MAR to only $0.3 \mu\text{V}/^\circ\text{C}$ for the Vishay types. This is especially important when using S or R type thermocouples that output only $6 \mu\text{V}/^\circ\text{C}$. R7 should have a temperature coefficient of ± 25 ppm/°C or better and a 1% tolerance. Note that the potentiometers are placed where their absolute resistance is not important so that their TCR is not critical. However, the trim pots should be of a stable cermet type. While multi-turn pots are usually considered to have the best resolution, many modern single-turn pots are just as easy to set to within $\pm 0.1\%$ of the desired value as the multi-turn pots.

Also single-turn pots usually have superior stability of setting, versus shock or vibration. Thus, good single-turn cermet pots (such as Allen Bradley type E, Weston series *See Appendix A for calculation of Seebeck coefficient.

840, or CTS series 360) should be considered as good candidates for high-resolution trim applications, competing with the more obvious (but slightly more expensive) multi-turn trim pots such as Allen Bradley type RT or MT, Weston type 850, or similar.

With a room temperature adjustment, drift error will be only $\pm 1/2^\circ\text{C}$ at 70°C and $\pm 1/4^\circ\text{C}$ at 0°C . Thermocouple nonlinearity results in additional compensation error. The chromel/alumel (type K) thermocouple is the most linear. With this type, a compensation accuracy of $\pm 3/4^\circ\text{C}$ can be obtained over a $0^\circ\text{C} - 70^\circ\text{C}$ range. Performance with an iron-constantan thermocouple is almost as good. To keep the error small for the less linear S and T type thermocouples, the ambient temperature must be kept within a more limited range, such as 15°C to 50°C . Of course, more accurate compensation over a narrower temperature range can be obtained with any thermocouple type by the proper adjustment of voltage TC and offset.

Standard metal-film resistors cost substantially less than precision types and may be substituted with a reduction in accuracy or temperature range. Using 50 ppm/°C resistors, the circuit can achieve $1/2^\circ\text{C}$ error over a 10°C range. Switching to 25 ppm resistors will halve this error. Tin oxide resistors should be avoided since they generate a thermal emf of $20 \mu\text{V}$ for 1°C temperature difference in lead temperature as opposed to $2 \mu\text{V}/^\circ\text{C}$ for nichrome or $4.3 \mu\text{V}/^\circ\text{C}$ for cermet types. Resistor networks exhibit good tracking, with 50 ppm/°C obtainable for thick film and 5 ppm/°C for thin film. In order to obtain the large resistor ratios needed, one can use series and parallel connections of resistors on one or more substrates.



Thermocouple Type	Seebeck Coefficient ($\mu\text{V}/^\circ\text{C}$)	R4 (Ω)	R6 (Ω)
J	52.3	1050	385
T	42.8	856	315
K	40.8	816	300
S	6.4	128	46.3

*R3 thru R6 are 1%, 5 ppm/°C. (10 ppm/°C tracking.)

†R7 is 1%, 25 ppm/°C.

$$\text{choose } R4 = \frac{\alpha}{10 \text{ mV}/^\circ\text{C}} \cdot R3$$

$$\text{choose } R6 = \frac{-T_0 \cdot \alpha}{V_Z} \cdot (0.9R5)$$

$$\text{choose } R7 = 5 \cdot R5$$

where T_0 is absolute zero (-273.16°C)

V_Z is the reference voltage (6.95V for LM329B)

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FIGURE 3. Thermocouple Cold-Junction Compensation Using Single Power Supply

A circuit for use with grounded thermocouples is shown in *Figure 4*. If dual supplies are available, this circuit is preferable to that of *Figure 3* since it achieves similar performance with fewer low TC resistors. To trim, short out the LM329B and adjust R5 so that $V_0 = \alpha T$, where α is the Seebeck coefficient of the thermocouple and T is the absolute temperature. Remove the short and adjust R4 so that V_0 equals the thermocouple output voltage at ambient. A good grounding system is essential here, for any ground differential will appear in series with the thermocouple output.

An electronic thermometer with a 10 mV/°C output from 0°C to 1300°C is seen in *Figure 5*. The trimming procedure is as

follows: first short out the LM329B, the LM335 and the thermocouple. Measure the output voltage (equal to the input offset voltage times the voltage gain). Then apply a 50 mV input voltage and adjust the GAIN ADJUST pot until the output voltage is 12.25V above the previously measured value. Next, short out the thermocouple again and remove the short across the LM335. Adjust the TC ADJUST pot so that the output voltage equals 10 mV/°K times the absolute temperature. Finally, remove the short across the LM329B and adjust the ZERO ADJUST pot so that the output voltage equals 10 mV/°C times the ambient temperature in °C.

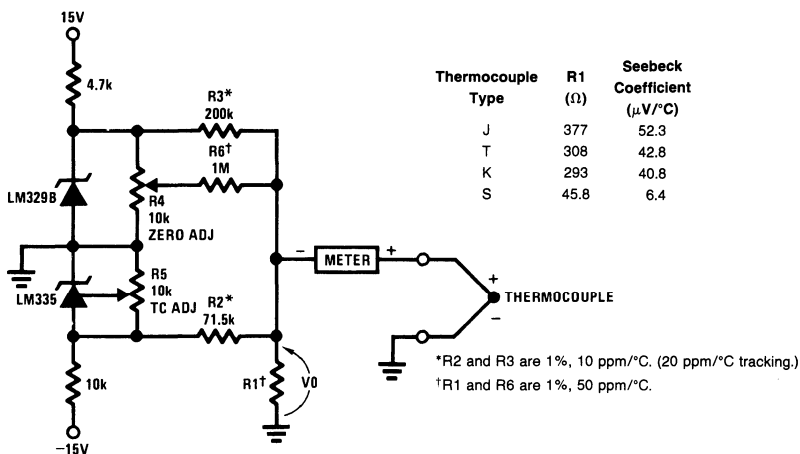


FIGURE 4. Cold-Junction Compensation for Grounded Thermocouple

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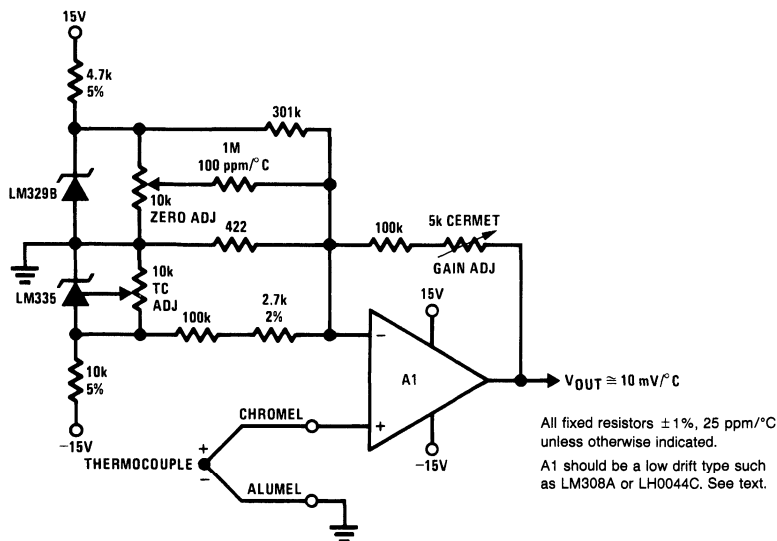


FIGURE 5. Centigrade Thermometer with Cold-Junction Compensation

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The error over a 0°C to 1300°C range due to thermocouple nonlinearity is only 2.5% maximum. Table I shows the error due to thermocouple nonlinearity as a function of temperature. This error is under 1°C for 0°C to 300°C but is as high as 17°C over the entire range. This may be corrected with a nonlinear shaping network. If the output is digitized, correction factors can be stored in a ROM and added in via hardware or software.

The major cause of temperature drift will be the input offset voltage drift of the op amp. The LM308A has a specified maximum offset voltage drift of $5 \mu\text{V}/^\circ\text{C}$ which will result in a 1°C error for every 8°C change in ambient. Substitution of an LH0044C with its $1 \mu\text{V}/^\circ\text{C}$ maximum offset voltage drift will reduce this error to 1°C per 40°C. If desired, this temperature drift can be trimmed out with only one temperature cycle by following the procedure detailed in Appendix B.

CONSTRUCTION HINTS

The LM335 must be held isothermal with the thermocouple reference junction for proper compensation. Either of the techniques of *Figures 6a* or *6b* may be used.

Hermetic ICs use Kovar leads which output $35 \mu\text{V}/^\circ\text{C}$ referenced to copper. In the circuit of *Figure 5*, the low level thermocouple output is connected directly to the op amp input. To avoid this causing a problem, both input leads of the op amp must be maintained at the same temperature. This is easily achieved by terminating both leads to identically sized copper pads and keeping them away from thermal gradients caused by components that generate significant heat.

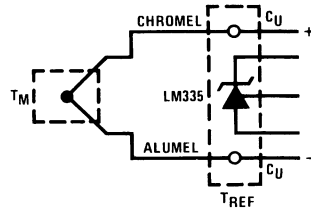
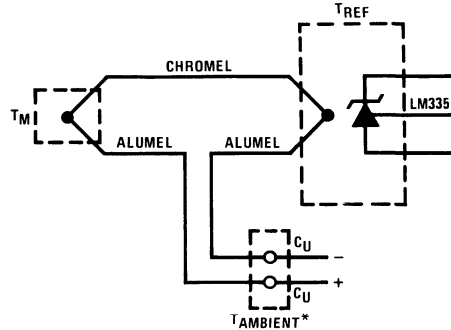


FIGURE 6a

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*Has no effect on measurement.

FIGURE 6b

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FIGURE 6. Methods for Sensing Temperature of Reference Junction

TABLE I. Nonlinearity Error of Thermometer Using Type K Thermocouple (Scale Factor $25.47^\circ\text{C}/\mu\text{V}$)

°C	Error (°C)	°C	Error (°C)
10	-0.3	200	-0.1
20	-0.4	210	-0.2
30	-0.4	220	-0.4
40	-0.4	240	-0.6
50	-0.3	260	-0.5
60	-0.2	280	-0.4
70	0	300	-0.1
80	0.2	350	1.2
90	0.4	400	2.8
100	0.6	500	7.1
110	0.8	600	11.8
120	0.9	700	15.7
130	0.9	800	17.6
140	0.9	900	17.1
150	0.8	1000	14.0
160	0.7	1100	8.3
170	0.5	1200	-0.3
180	0.3	1300	-1.3
190	0.1		

Before trimming, all components should be stabilized. A 24-hour bake at 85°C is usually sufficient. Care should be taken when trimming to maintain the temperature of the LM335 constant, as body heat nearby can introduce significant errors. One should either keep the circuit in moving air or house it in a box, leaving holes for the trim pots.

CONCLUSION

Two circuits using the LM335 for thermocouple cold-junction compensation have been described. With a single room temperature calibration, these circuits are accurate to $\pm 3/4^\circ\text{C}$ over a 0°C to 70°C temperature range using J or K type thermocouples. In addition, a thermocouple amplifier using an LM335 for cold-junction compensation has been described for which worst case error can be as low as 1°C per 40°C change in ambient.

APPENDIX A

DETERMINATION OF SEEBECK COEFFICIENT

Because of the nonlinear relation of output voltage vs. temperature for a thermocouple, there is no unique value of its Seebeck coefficient α . Instead, one must approximate the thermocouple function with a straight line and determine α from the line's slope for the temperature range of interest.

On a graph, the error of the line approximation is easily visible as the vertical distance between the line and the nonlinear function. Thermocouple nonlinearity is not so gross, so that a numerical error calculation is better than the graphical approach.

Most thermocouple functions have positive curvature, so that a linear approximation with minimum mean-square error will intersect the function at two points. As a first cut, one can pick these points at the $1/3$ and $2/3$ points across the ambient temperature range. Then calculate the difference between the linear approximation and the thermocouple.[†] This error will usually then be a maximum at the midpoint and endpoints of the temperature range. If the error becomes too large at either temperature extreme, one can modify the slope or the intercept of the line. Once the linear approximation is found that minimizes error over the temperature range, use its slope as the Seebeck coefficient value when designing a cold-junction compensator.

An example of this procedure for a type S thermocouple is shown in Table II. Note that picking the two intercepts (zero error points) close together results in less error over a narrower temperature range.

[†]A collection of thermocouple tables useful for this purpose is found in the Omega Temperature Measurement Handbook published by Omega Engineering, Stamford, Connecticut.

TABLE II. Linear Approximations to Type S Thermocouple

Centigrade Temperature	Type S Thermocouple Output (μV)	Approximation # 1 Zero Error at 25°C and 60°C			Approximation # 2 Zero Error at 30°C and 50°C		
		Linear Approx.	Error		Linear Approx.	Error	
			μV	$^\circ\text{C}$		μV	$^\circ\text{C}$
0°	0	-17	-17	-2.7°	-16	-16	-2.8°
5°	27	15	-12	-1.9°	16	-11	-1.7°
10°	55	46	-9	-1.4°	47	-8	-1.3°
15°	84	78	-6	-0.9°	78	-6	-0.9°
20°	113	110	-3	-0.5°	110	-3	-0.5°
25°	142	142	0	0	142	-1	-0.2°
30°	173	174	1	0.2°	173	0	0
35°	203	206	3	0.5°	204	1	0.2°
40°	235	238	3	0.5°	236	1	0.2°
45°	266	270	4	0.6°	268	2	0.3°
50°	299	301	2	0.3°	299	0	0
55°	331	333	2	0.3°	330	-1	-0.2°
60°	365	365	0	0	362	-3	-0.5°
65°	398	397	-1	-0.2°	394	-4	-0.6°
70°	432	429	-3	-0.5°	425	-7	-1.1°
		$\alpha = 6.4 \mu\text{V}/^\circ\text{C}$			$\alpha = 6.3 \mu\text{V}/^\circ\text{C}$		
		0.6°C error for 20°C < T < 70°C			0.3°C error for 25°C < T < 50°C		

Note: Error is the difference between linear approximation and actual thermocouple output in μV . To convert error to $^\circ\text{C}$, divide by Seebeck coefficient.

APPENDIX B TECHNIQUE FOR TRIMMING OUT OFFSET DRIFT

Short out the thermocouple input and measure the circuit output voltage at 25°C and at 70°C. Calculate the output voltage temperature coefficient, β as shown.

$$\beta = \frac{V_{OUT}(70^{\circ}\text{C}) - V_{OUT}(25^{\circ}\text{C})}{45^{\circ}\text{K}} \text{ in mV}/^{\circ}\text{K}$$

Next, short out the LM329B and adjust the TC ADJ pot so that $V_{OUT} = (20 \text{ mV}/^{\circ}\text{K} - \beta) \times 298^{\circ}\text{K}$ at 25°C. Now remove the short across the LM329B and adjust the ZERO ADJUST pot so that $V_{OUT} = 246 \text{ mV}$ at 25°C (246 times the 25°C output of an ice-point-referenced thermocouple).

This procedure compensates for all sources of drift, including resistor TC, reference drift ($\pm 20 \text{ ppm}/^{\circ}\text{C}$ maximum for the LM329B) and op amp offset drift. Performance will be limited only by TC nonlinearities and measurement accuracy.

REFERENCES

R. C. Dobkin, "Low Drift Amplifiers," National Semiconductor LB-22, June 1973.

Carl T. Nelson, "Super Matched Bipolar Transistor Pair Sets New Standards for Drift and Noise," National Semiconductor AN-222, February 1979.

Applications of Wide-Band Buffer Amplifiers

National Semiconductor
Application Note 227
Jim Sherwin



INTRODUCTION

The LH0002, LH0033 and LH0063 are wide-band, high current, unity gain buffer amplifiers. They are intended for use alone or in closed-loop combination with op amps to drive co-axial cables and capacitive or other high-current loads. Features and characteristics of these buffers are summarized in Table I. All are active trimmed for low unadjusted output offset voltage and uniform performance. Good thermal coupling between dice is achieved by hybrid thick-film construction on ceramic substrates.

Part I analyzes the AC and DC equivalent circuits.

Part II is a comprehensive guide to applications techniques and shows how to get optimum performance under a variety of circumstances.

Finally, Part III illustrates these techniques in some specific applications including drivers, sample-and-hold amplifiers and active filters.

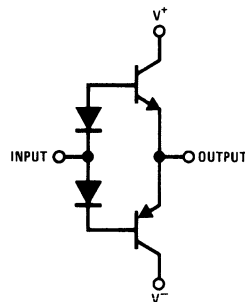
I. CIRCUIT DESCRIPTIONS

General

The three buffer amplifiers share a similar class AB emitter-follower output stage as shown in *Figure 1*. The symmetrical class AB amplifier output provides current sourcing or sinking and relatively constant low impedance to the load during positive and negative output swing. The input stage of the LH0002 consists of a complementary bipolar emitter-follower. The LH0033 and LH0063 employ junction FETs configured as source-followers, thereby achieving several orders of magnitude improvement in DC input resistance over the LH0002. In each case, the output stage collectors are uncommitted to allow the use of current limiting resistors in series with either or both output collectors.

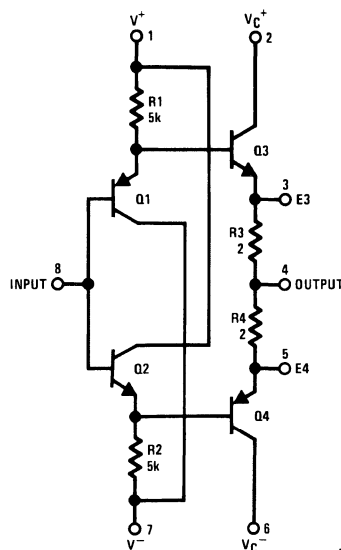
LH0002 Low Frequency Operation

The LH0002 circuit shown in *Figure 2* is a compound emitter-follower with small-signal current gain of approximately 40,000 (product of first and second stage betas).



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FIGURE 1. LH0002 Simplified Output Stage



TL/H/8725-2

FIGURE 2. LH0002 Schematic Diagram

TABLE I. Buffer Amplifier Typical Characteristics

Parameter	Conditions	LH0002	LH0033	LH0063	Units
DC Output Current Continuous		± 100	± 100	± 250	mA
Peak Output Current		± 200	± 250	± 500	mA
Slew Rate	$R_L = 1 \text{ k}\Omega$, $R_S = 50 \Omega$	200	1500	6000	V/ μ s
Bandwidth, 3 dB		50	100	180	MHz
Voltage Gain	$V_{IN} = 1 \text{ V @ } 1 \text{ kHz}$, $R_L = 1 \text{ k}$	0.97	0.98	0.98	V/V
Output Offset Voltage	$T_C = 25^\circ\text{C}$, $R_S = 100 \text{ k}\Omega$ ($R_S = 300 \Omega$ for LH0002)	± 10	± 5	± 10	mV
Input Bias Current	$T_C = 25^\circ\text{C}$	6 μ A	50 pA	100 pA	
Output Resistance		6	6	1	Ω

Operation is symmetrical, and the circuit may be analyzed by considering only the upper or the lower half of the circuit as redrawn in *Figure 3*. Input stage operating current is determined by R1 in conjunction with supply and input voltages. For $V_{IN} = 0$ and $V_S = \pm 15V$, first stage quiescent current is typically:

$$I_C = \frac{V_S - V_{BE} - V_{IN}}{R1} = \frac{15 - 0.63 - 0}{5000\Omega} = 2.88 \text{ mA} \quad (1)$$

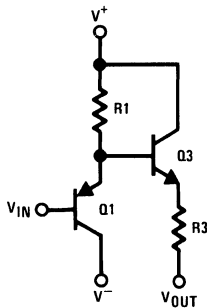
The normal production variation of I_C is $\pm 5\%$.

The emitter-base junction of the first and second stages appear in series between input and output terminals, therefore the output offset voltage for $V_{IN} = 0$ is the difference in base-emitter junction voltages of a PNP and an NPN transistor. This is true for both upper and lower halves of the circuit, so there is no conflict between the two circuit halves. Output stage quiescent current will equal that of the input stage if the transistors are matched and at equal temperatures. This establishes a class AB bias in the output stage so there is no class B crossover distortion in the output. Resistors R3 and R4 inserted in the output emitter circuits minimize the effect of unmatched upper and lower circuit halves and limit the potential for thermal runaway due to input and output stage temperature differences. There is no thermal runaway if operation is confined within data sheet limits.

Maximum output current is dependent on the supply voltage, R1, Q3 current gain, and the output voltage. Maximum current is available when V_{IN} rises sufficiently above V_{OUT} that Q1 is cut off. Under this condition, the 5k resistor supplies base current to Q3, and the maximum output current is:

$$I_{O(MAX)} = \frac{V_S - V_{BE3} - I_O R3 - V_O}{R1/\beta_3} \\ = \frac{V_S - V_{BE3}}{R1/\beta_3 + R3 + R_L} \approx \frac{V_S - 0.7}{30 + R_L} \quad (2)$$

where $\beta_3 \approx 200$.



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FIGURE 3. LH0002 Half Circuit

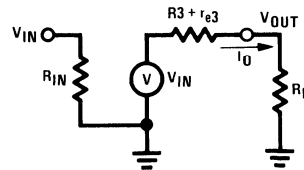
If $V_S = \pm 15V$, the LH0002 can theoretically deliver about 500 mA peak into a shorted load (in practice, only 400 mA peak can be realized, for the current density in the output transistors limits the beta to about 150) or 180 mA peak into 50Ω. Current limiting may be employed for short circuit protection (see section on Current Limiting).

The voltage gain of the LH0002 is slightly less than unity and is a function of load as with any emitter-follower. It is dominated by the finite output resistance of the output stage. Hence, the gain analysis for all three buffers can utilize the hybrid π model as shown in *Figure 4*. Note that r_{e3} is the emitter dynamic resistance of Q3 and is load-current dependent. The gain expression written as a function of load resistance and input voltage is:

$$A_v \approx \frac{R_L}{R_L + R3 + r_{e3}} = \frac{R_L}{R3 + R_L \left(1 + \frac{0.026}{V_O + 0.003R_L} \right)} \quad (3) \\ = \frac{R_L}{R3 + R_L \left(1 + \frac{0.026}{V_{IN}} \right)} \Big|_{V_{IN} > 0.1V}$$

Voltage gain could range from 0.996 for $R_L = 1 \text{ k}\Omega$ to 0.978 for $R_L = 100\Omega$ at 10V input. In contrast, the same loads would yield gains of 0.973 to 0.956, respectively, for an input of 1V because r_{e3} would be somewhat larger.

Because of the inherent current-mode feedback, initial offset error is typically 10 mV with a finite (300Ω) series input resistance. Even with unsymmetrical supplies, V_{OS} increases only an additional 3 mV per volt of supply differential. Usually this error component may be ignored as it is relatively small compared to the large-signal error predicted by equation (3) when driving heavy loads.



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Where: $r_{e3} = 0.026/I_O$

FIGURE 4. Equivalent Model of LH0002

LH0002 High Frequency Operation

The high frequency response is limited primarily by internal circuit capacitances; most significant are the junction capacitances shown in *Figure 5*.

Since the base-emitter junction capacitances of emitter-follower see little effective junction voltage change, they may be neglected in the following first-order analysis. For the transistors used we may also assume that the transistor delay and transit time effects are over-shadowed by the RC effect. We can then simplify the half-circuit to that of *Figure 6*: a single transistor emitter-follower plus an equivalent load reflected from the output stage.

Evaluation of the transfer function of equation (4) as derived from *Figure 6b* indicates that the input pole dominates for finite source resistance.

$$\frac{e_o(s)}{e_{in}(s)} = \frac{\left(\frac{R_2}{R_2 + R_s}\right) \left(\frac{\beta_3 R_L}{\beta_3 R_L + r_{out}}\right)}{[1 + s(R_2 \parallel R_s) C'_{CB1}] [1 + s(r_{out} \parallel \beta_3 R_L) C_{CB3}]} \quad (4)$$

$$\cong \frac{A_V \text{ (low frequency)}}{(1 + s R_s C_{CB1}) (1 + s r_{e1} C_{CB3})}$$

To illustrate, for $R_s = 300\Omega$, the primary pole is predicted to occur at about 60 MHz, a close correlation to the real value, while the output pole is well beyond 1 GHz. The implication of this analysis is quite significant—the fundamental bandwidth of the LH0002 is a function of the input source resistance within a reasonable range of 50Ω to 300Ω. For the case of $R_s = 50\Omega$, the resulting bandwidth is well above 100 MHz.

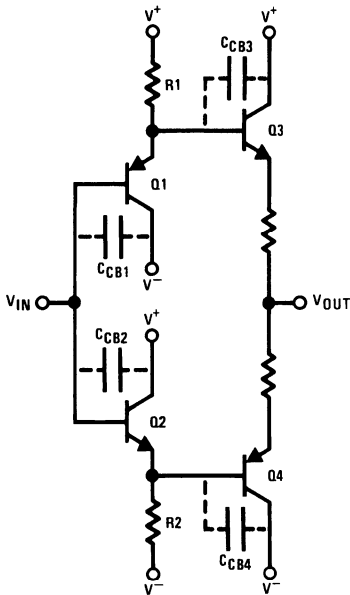


FIGURE 5. LH0002 High Frequency Circuit

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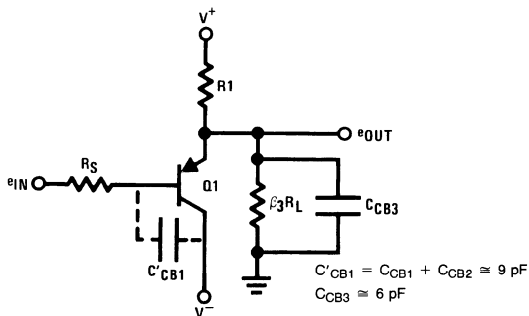
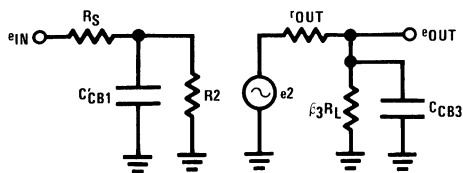


FIGURE 6a. LH0002 Simplified Mirror-Half Input Stage

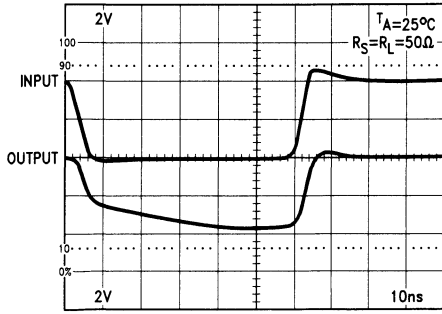
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Where: $r_{OUT} \cong \left(r_{e1} + \frac{R_s}{\beta_1}\right) \parallel R_1$
 $R_2 = \beta_1 (r_{e1} + R_1 \parallel \beta_3 R_L)$

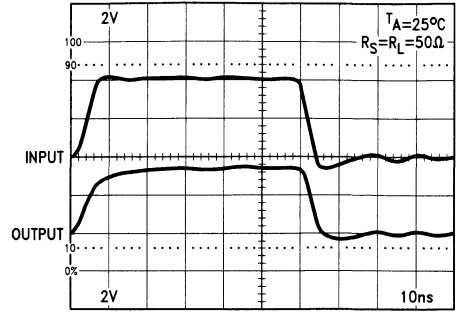
FIGURE 6b. Hybrid π Model

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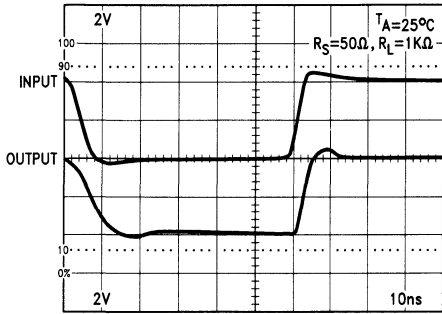
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a. Negative Pulse Response



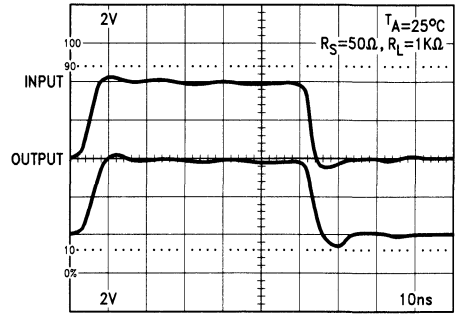
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b. Positive Pulse Response



TL/H/8725-10

c. Negative Pulse Response



TL/H/8725-11

d. Positive Pulse Response

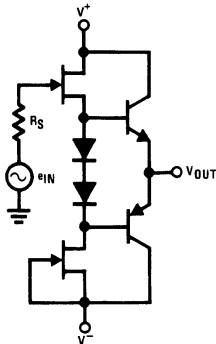
FIGURE 7. LH0002 Pulse Response

LH0002 Large Signal Pulse Response

Figure 7 shows the typical large signal pulse response of the LH0002.

LH0033 Low Frequency Operation

The LH0033 circuit can be described in simplified form, Figure 8, as a source-follower plus a balanced emitter-follower. The complete circuit is shown in Figure 9.

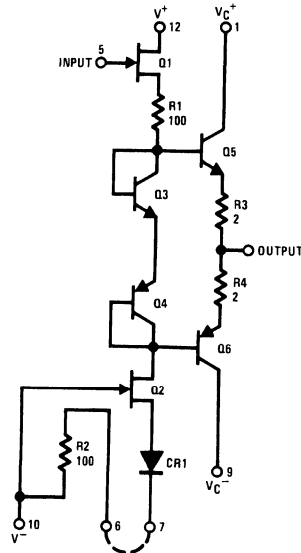


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FIGURE 8. LH0033 Simplified Circuit

When Q1 and Q2 are well matched, offset voltage and drift will be low because the gate-source voltage of Q2, V_{GS2} , is set $\approx 2 V_{BE}$, thus forcing $V_{GS1} = V_{GS2}$ due to the matching when operating at equal currents. However, as load current

is drawn from the output, Q1 and Q2 will drift at slightly different rates as I_{D1} will no longer equal I_{D2} by the difference in output stage base current. Resistor R2 is trimmed to establish the drain current of current-source transistor Q2 at 10 mA, and R1 is trimmed for zero offset.



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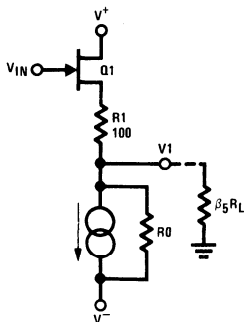
FIGURE 9. Complete LH0033 Schematic Diagram

The same current flowing through Q2 also flows through Q1 and R1, causing a gate-source voltage of approximately 1.6V. The 10 mA flowing through R1 plus Q3's V_{BE} of 0.6V causes $V_{OUT} = 0$ for $V_{IN} = 0$. The output stage current is established to be approximately equal to that of the input stage by Q3 and Q4.

Voltage gain of the LH0033 is the product of the 1st and 2nd stage gains taken independently. The analysis of each is shown in Figure 10. We can write the total amplifier gain expression as:

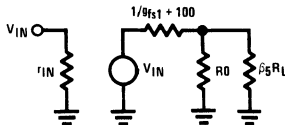
$$A_V = \frac{1}{1 + 2/R_L + 167/\beta_5 R_L + 0.26/V_{IN}} \quad (5)$$

where $\beta_5 \approx 200$.



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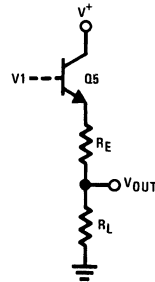
a. Hybrid π Model of FET Source-Follower Including Effect of Output Load



$$A_{v1} = \frac{R_0 \parallel \beta_5 R_L}{R_0 \parallel \beta_5 R_L + 1/g_{fs1} + R_1} = \frac{1}{1 + 167/R_0 + 167/\beta_5 R_L}$$

for: $g_{fs1} \approx 0.015$ mho

$$R_0 \approx \frac{1}{g_{os2}} (1 + g_{re2} R_2) = 125 \text{ k}\Omega$$

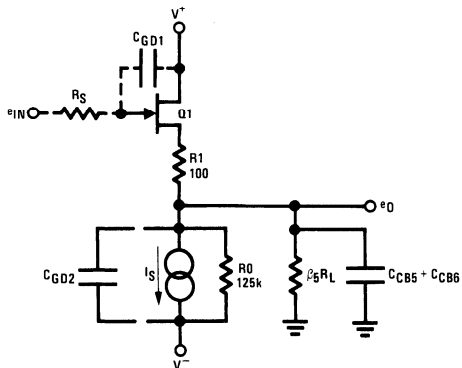


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$$A_{v2} = \frac{R_L}{R_L + R_E + r_{e5}} = \frac{1}{1 + R_E/R_L + 0.026/V_1}$$

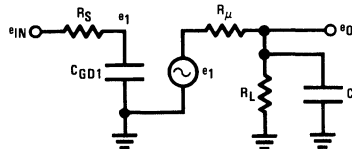
b. Output Stage Gain with the Effect of Emitter Dynamic Resistance

FIGURE 10. Voltage Gain Analysis of the LH0033



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FIGURE 11. LH0033 Simplified Circuit



TL/H/8725-18

Where: $R_\mu = R_1 + 1/g_{fs1}$
 $R_L = R_0 \parallel \beta_5 R_L$
 $C_L = C_{GD2} + C_{CB5} + C_{CB6}$

FIGURE 12. LH0033 High Frequency Circuit Model

Capacitors C_{CB5} and C_{CB6} are collector-base junction capacitances of Q5 and Q6, typically 3 pF each. C_{GD1} and C_{GD2} are the gate-drain capacitances of the FETs, typically 3.5 pF each. The frequency-dependent transfer function of the circuit is:

$$\frac{e_o(s)}{e_{in}(s)} = \frac{R_L / (R_L + R_1)}{[1 + s R_S C_{GD1}] [1 + s (R_\mu \parallel R_L) C_L]} \quad (6)$$

Notice that unlike the LH0002, the output pole ($s = 1/R_\mu C_L$) dominates the primary frequency response roll-off occurring at about 100 MHz with an input source resistance $R_S = 50\Omega$. The user is cautioned that as R_S increases, the secondary (input) pole will begin to take effect. To illustrate, for $R_S = 300\Omega$, the secondary pole will have moved from 900 MHz at $R_S = 50\Omega$ to about 150 MHz.

LH0033 Slew Rate

The slew rate of the buffer is predicted by equation (7),

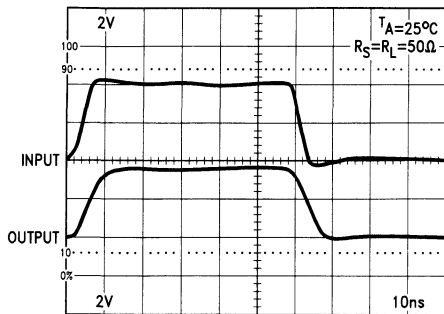
$$\frac{dv}{dt} = \frac{I}{C_L} \quad (7)$$

where I is the input stage current available to charge the circuit capacitance C_L .

With the LH0033, the positive slew is 2–3 times greater than the negative slew. The pulse response in *Figure 13* illustrates this. The reason is that during positive slew, the peak charging current is limited by the value of R_1 plus R_S when the FET gate-source junction is forward biased. This could be 30 mA–40 mA peak, allowing a typical slew rate of 3,000 V/ μ s.

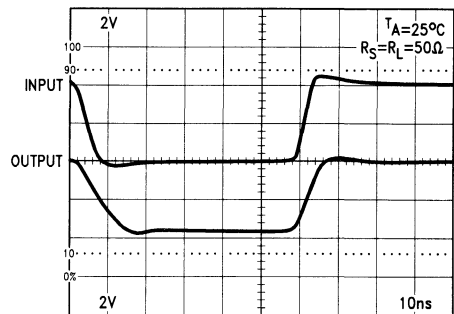
The LH0033 negative-going slew is limited by its input stage quiescent current of 10 mA established by the FET current source. As the input transistor tends to shut off, the circuit capacitance discharges into the current source (sink) at a rate of 10 mA. Therefore, the slew rate is computed to be:

$$\frac{dv}{dt} = \frac{10 \text{ mA}}{9.5 \text{ pF}} = 1,050 \text{ V}/\mu\text{s}$$



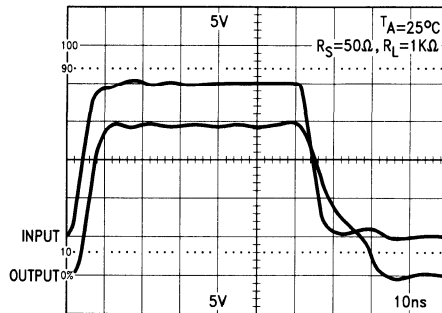
TL/H/8725-19

a. Positive Pulse Response



TL/H/8725-20

b. Negative Pulse Response



TL/H/8725-21

c. $\pm 10\text{V}$ Pulse Response

FIGURE 13. LH0033 Large Signal Pulse Response

LH0063 Low Frequency Operation

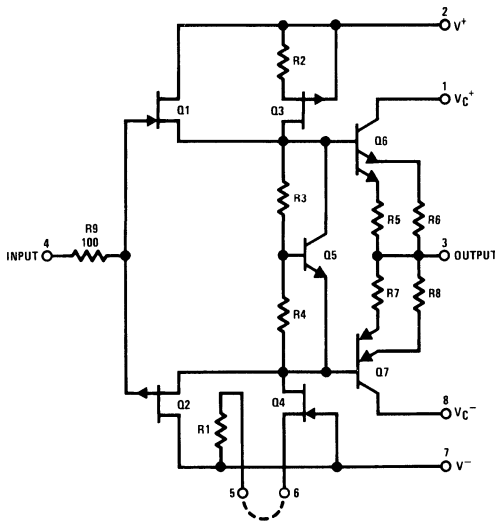
The LH0063 exhibits several times the slew rate and bandwidth of the LH0033 due to a higher input stage operating current. The push-pull design of the first stage also allows the input FETs to be forward biased for either positive or negative-going input signals. The schematic diagram of *Figure 14* shows a pair of complementary FETs at the input stage. Transistor Q1 is biased by the current source Q4. Resistor R1 is trimmed for a 30 mA input stage operating current. Similarly, Q2 is biased to 30 mA by the current source Q3 and R2. Transistor Q5 and resistors R3 and R4 establish a 2V_{BE} forward diode equivalent between the Q6 and Q7 bases. These resistors are trimmed such that the output stage operates at a quiescent current of about 1 mA. Each FET gate-source voltage cancels each output transistor V_{BE} drop. Hence, the output of the buffer sits at 0V for an input 0V. The zero-offset voltage-follower action holds for any input voltage within the buffer operating voltage range.

Because of the high current drive capability, multiple output transistors are employed to limit output transistor current density. Four output degeneration resistors of 1Ω each help to prevent thermal runaway.

The DC voltage gain equation is similar to that of the LH0033. Equation (5) may be used without introducing significant error. It needs modification only because of the multiple transistor output stage. Therefore, the LH0063 voltage gain equation is approximately:

$$A_v \cong \frac{1}{1 + 0.5/R_L + 1g_{fs1}\beta_6R_L + 0.026/2V_{IN}} \quad (8)$$

where: $\beta_6 \cong 200$, $g_{fs1}\beta_6 \cong 0.010$ mho.



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FIGURE 14. Complete LH0063 Schematic Diagram

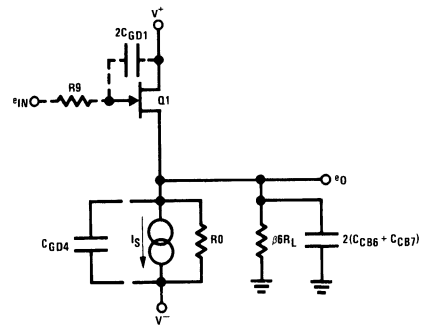
LH0063 High Frequency Operation

The high frequency equivalent circuit may omit the output stage, including only its load effect. The two mirrored half-circuits, consisting of a pair of complementary junction FETs and their respective current sources, can be reduced to a single half-circuit with the combined effect of both as shown in *Figure 15*.

The frequency-dependent transfer function of the LH0063 as derived from *Figure 15b* is:

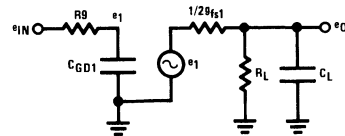
$$\begin{aligned} \frac{e_o(s)}{e_{IN}(s)} &= \frac{R_L / (R_L + 1/2g_{fs1})}{[1 + s2R_g C_{GD1}] [1 + s \left(\frac{2}{2g_{fs1}} \parallel R_L \right) C_L]} \\ &= \frac{A_v \text{ (low freq.)}}{[1 + s2R_g C_{GD1}] [1 + s \left(\frac{1}{2g_{fs1}} \right) C_L]} \end{aligned} \quad (9)$$

Similar to the LH0033, equation (9) indicates that the device output pole ($s = -2g_{fs1}/C_L$) dominates for small value input source resistance ($R_9 = 100\Omega$). Using the parameter values given in *Figure 15b*, equation (9) predicts the primary pole to occur at about 190 MHz, and the secondary (input) pole at beyond 300 MHz.



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a. Lumping the Combined Effects of Two Complementary Input Stages

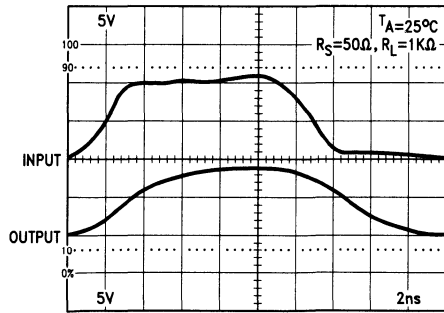


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- $g_{fs1} \cong 0.010$ mho, $R_L = R_0 \parallel \beta_6 R_L$
- $C_L = 2(C_{CB6} + C_{CB7}) + C_{GD4}$
- $C_{CB6} \cong C_{CB7} = 3$ pF
- $C_{GD1} \cong C_{GD4} = 3.5$ pF

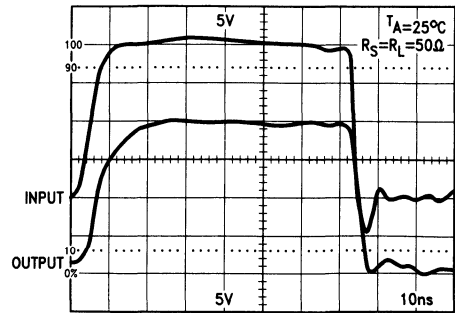
b. Hybrid π Model of the Source Follower Substituted in the Composite Model

FIGURE 15. LH0063 Simplified High Frequency Circuit Model



a. Positive Pulse Response

TL/H/8725-25

b. $\pm 10V$ Pulse Response

TL/H/8725-26

FIGURE 16. LH0063 Large Signal Pulse Response

LH0063 Large Signal Pulse Response

Figure 16 demonstrates the large signal pulse response capability of the LH0063 under different load conditions. Note the higher positive as well as negative-going slew rate achieved with the complementary FET input stage operating at higher current, a response superior to that of the LH0033.

II. APPLICATIONS INFORMATION

Circuit Layout Considerations

Circuit layout is one of the most important areas of high frequency circuit design. A sound design may yield only marginal performance when insufficient attention is given to circuit layout. This will be particularly important when the buffers are used with an op amp in a closed loop or when using very high frequency devices. The full performance capability of this family of buffers may be realized by following a few basic rules on circuit layout.

Good high frequency layout practice requires use of a ground plane wherever possible. A ground plane provides shielding (isolation) as well as a low-resistance, low-inductance circuit path to reduce undesirable high frequency coupling. In some cases, signal paths should be shielded by a surrounding ground plane to minimize stray signal pick-up; however, this shielding can cause increased stray capacitance which may be harmful at high impedance points in the circuit. Some care and judgement must be exercised in the amount and spacing of shielding ground plane areas. IC sockets should be avoided if possible because the increased inter-lead capacitance may degrade bandwidth or increase feedback capacitance in gain stages. Input and output connections should be kept short for compact physical layout and minimum coupling. When used with an op amp, layout should minimize capacitance from output to

feedback point and from feedback summing junction to ground. Supply and output signal traces should be as wide as practical for these high-current devices.

Power Supply Decoupling

The positive and negative power supply terminals of the devices must be bypassed to ground with one or two 0.1 μF monolithic ceramic capacitors. They should be placed no more than 1/4 to 1/2 inch from the device pins. In difficult cases with the LH0033 and in all cases with the LH0063, a 4.7 μF solid tantalum bypass should also be added at both the plus and minus supplies. The circuit board trace between capacitor ground points should be short and of low inductance.

Compensation

The three buffer amplifiers are inherently stable in applications with resistive loads and adequate supply bypassing. However, oscillation may occur in cases where a capacitive load of 100 pF or more is present. A series input resistance of 50 Ω –300 Ω will prevent this oscillation by compensating the negative input-resistance seen as a result of the reflected capacitive load. All source, cathode, or emitter-followers are subject to this phenomenon which is a result of transit time through the active region of the devices.

When these buffer amplifiers are placed within the feedback loop of a high-gain op amp, the phase margin of the operational amplifier is reduced by an additional amount equal to the phase lag of the buffer. Readjustment of circuit compensation may be required to insure stability. For additional information see the section on Closed-Loop Feedback Applications.

Power Dissipation and Device Rating

Each data sheet specifies the conditions for safe operating power dissipation. These limits must be observed for both continuous and pulsed conditions. Figure 17 shows the power dissipation limits versus temperature for each device, both with and without heat sinks. To compute total power dissipation, the standby power must be added to the load-related power.

The standby power drain is computed from the device DC operating current and its operating voltage:

$$P_{standby} = (V_{S^+} - V_{S^-})I_S \tag{10}$$

The load-related power is the average power dissipated in the output stage. It may be estimated as the product of average current delivered to the load and the average voltage across the output stage. Because of the high-current capability of the buffers, it is essential to observe the device dissipation limits. Safe operating areas for each buffer are presented in Figure 18. A note of caution: these plots are valid only for 25°C ambient. Additional power derating based on the power derating curves of Figure 17 is mandatory for operation at higher ambient temperature.

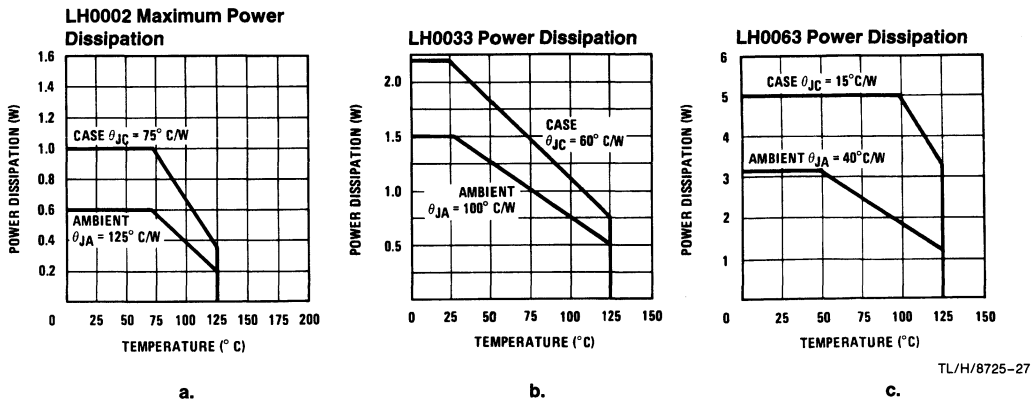


FIGURE 17. Device Power Dissipation

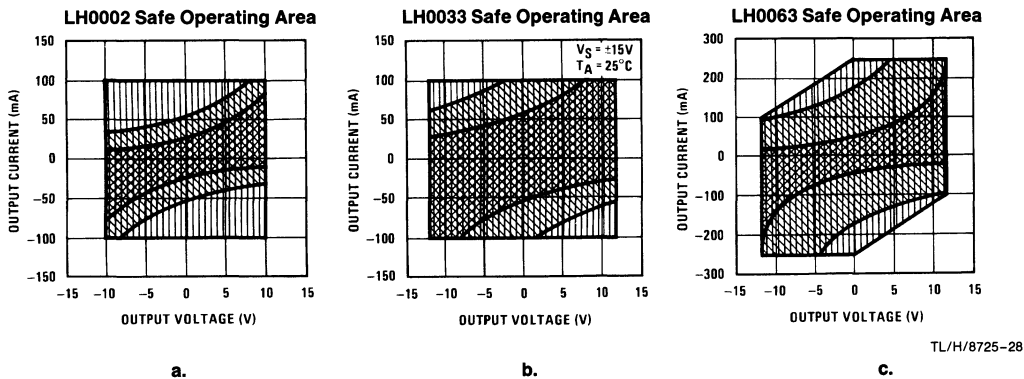


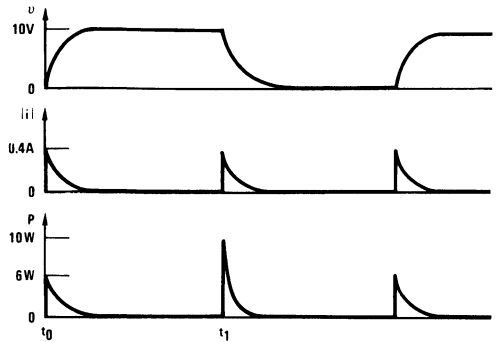
FIGURE 18. Safe Operating Areas at 25°C and $V_S = \pm 15V$

Peak Power Dissipation

An often overlooked power dissipation factor exists when driving a reactive load. Consider the LH0002 with a possible 400 mA peak current drive capability when driving 10V square pulses into 1000 pF. At the rising edge, the upper device transistor charges the capacitor at its limiting current. The charging waveform is not linear, in fact it approaches a logarithmic curve because the resistor $R1/\beta\beta$ appears as the principal value of charging resistance [see equation (2)]. The instantaneous power dissipation is simply the product of V^+ and $I_{O(MAX)}$, or 6W, with occurrences at the positive and negative leading edges. Once the load capacitor is charged, the negative leading edge instantaneous peak power is somewhat greater because the power dissipated in the lower output transistor is $(V_O - V^-) I_O = 25I_O$. The PNP pull-down transistor has slightly lower β , limiting peak current to less than 400 mA, therefore the peak negative edge power is just under 10W in this instance.

Figure 19 indicates the output voltage and current relationships as well as the power dissipation versus time for the pulse waveform into a capacitive load.

Obviously, the average power dissipation under peak current drive conditions is dependent upon the pulse repetition frequency, and becomes increasingly dominant as the PRF increases.



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PEAK POWER

$$P_{t_0} = (15V - 0V) (0.4A) \\ = 6 W_{PEAK}$$

$$P_{t_1} = [10V - (-15V)] (0.4A) \\ = 10 W_{PEAK}$$

FIGURE 19. Peak Power Dissipation Into Pure Capacitive Load

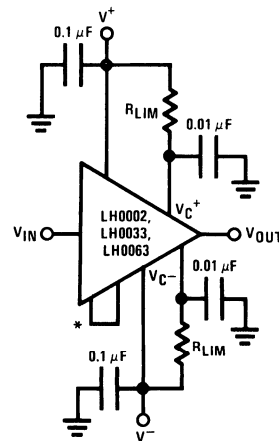
Because each of the buffer amplifiers may be operated on dissimilar supply voltages for input and output stages, device power dissipation is reduced by lowering the output stage supply voltages while retaining the input stage supplies at a higher level for best current driving capability. The limiting factor is, of course, a reduced output voltage swing.

Current Limiting

Current limiting may be provided in either of two ways: by adding series resistors at the collectors of the output stage, or by a single series resistor at the buffer output. The first method (Figure 20) is preferred as there is little effect on output resistance and peak current drive. However, the output voltage swing is reduced by the voltage drop across these resistors. Their value is determined as follows:

$$R_{LIM} = \frac{V^+}{I_{SC}^+}, \frac{V^-}{I_{SC}^-} \quad (11)$$

where $I_{SC} = 100$ mA for LH0002 and LH0033, and 250 mA for LH0063.



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*LH0033 and LH0063 only

FIGURE 20. Current Limiting using Collector Resistors

The output collectors should be bypassed with $0.01 \mu\text{F}$ capacitors in addition to the normal supply bypassing, as shown in *Figure 20*. The $0.01 \mu\text{F}$ capacitors will allow full output voltage and current on an instantaneous basis for transient pulses yet at the same time prevent output stage resonant oscillation.

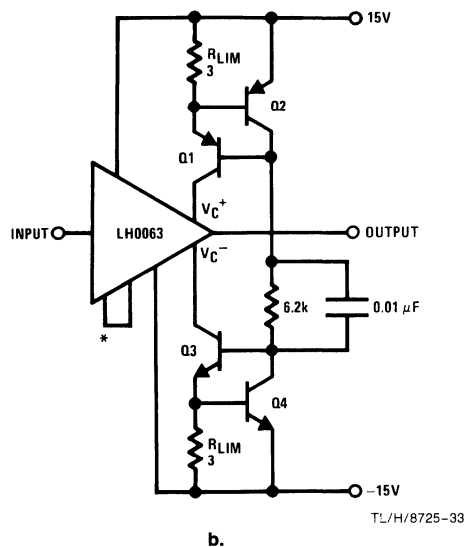
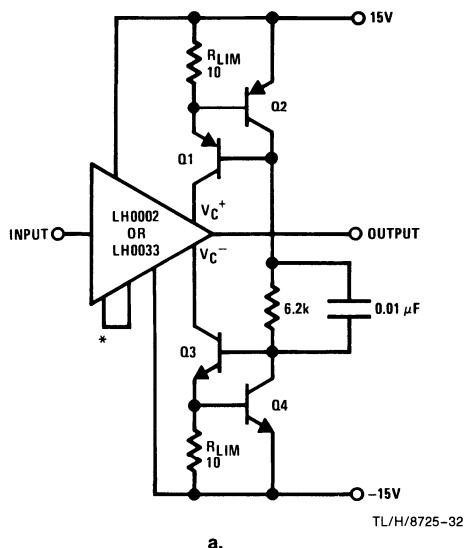
Alternate active current limit techniques that retain almost the full DC output swing are shown in *Figure 21*. In these circuits, the current sources are saturated during normal operation and thus apply nearly full supply voltage to the load. Under fault conditions, the voltage decreases as determined by the overload.

For *Figure 21a*, the limit-set resistor is set for 60 mA.

$$R_{LIM} = V_{BE}/I_{SC} = 0.6\text{V}/0.06\text{A} = 10\Omega$$

In *Figure 21b*, the current limit has been set to 200 mA.

$$R_{LIM} = \frac{V_{BE}}{I_{SC}} = \frac{0.6\text{V}}{0.2\text{A}} = 3.0\Omega$$



*LH0033 and LH0063 only

FIGURE 21. Current Limiting using Current Sources

For applications where the buffers are inside the feedback loop of an op amp such as LH0032, LH0024, LH0062 or LM118, a single current limiting resistor may be placed inside the feedback loop at the buffer output as shown in *Figure 22*. Its value is also computed as $R_{LIM} = V^+ / I_{SC}$.

Heat Sinking

In order to utilize the full drive capabilities of these devices, low thermal resistance heat sinks should be used. The cases of all three devices are isolated from the circuit and may be connected to system ground or to the buffer output as desired. The following list gives thermal resistance of various heat sinks available for the buffers.

TABLE II. Heat Sinks For LH0033 and LH0063

LH0033	LH0063
Thermalloy 2240A, 33°C/W	Thermalloy 6002B-19, 6°C/W
Wakefield 215CB, 30°C/W	IERC LAIC3V4BC
IERC UP-TO8-48CB, 15°C/W	IERC HP1-TO3-33CB, 7°C/W

Capacitive Loads

All three devices are capable of driving relatively high capacitive loads. Because capacitive loads on emitter-followers are reflected to the input as negative resistances, it is necessary to add some series compensating positive real resistance; 50Ω – 300Ω is usually sufficient. An alternative is to insert the current limiting resistor at the output as shown in *Figure 22*. This will isolate the capacitive load from the buffer.

Any of the buffers can drive twisted pair, shielded or coaxial cables, or other reactive loads. For all practical purposes, an unterminated coaxial cable presents a capacitive load to the driver. On the other hand, terminated coaxial cables appear as resistive loads, and therefore may not require the compensation for capacitive loads. Don't forget consideration of peak power dissipation when driving cable loads, since they may represent capacitive loads (see section on Peak Power Dissipation).

Offset Voltage and Adjustment

Offset voltage is measured with $V_{IN} = 0$. As V_{IN} and I_L are increased, the apparent offset voltage will change. This is due primarily to a gain which is less than unity (inherent in an emitter-follower). The effect of this is discussed in detail in the section on Circuit Description. Both the LH0033 and LH0063 have provisions for offset voltage adjustment. When not required, the OFFSET ADJUST pins of these two devices should be shorted. When adjustment is desired, they should be open-circuited, and the external adjustment

is accomplished with a 200Ω variable resistor inserted between V^- and pin 7 of the LH0033 or pin 6 of the LH0063. It is good practice to insert a 20Ω resistor in series with the variable resistor to limit excessive power dissipation at the input stage when the pot is at minimum value. The offset adjustment range is typically ± 400 mV.

When a buffer amplifier is used as a current booster in conjunction with an operational amplifier, as in *Figure 22*, there is usually no need for output offset adjustment, since the offset is reduced by the open-loop to closed-loop gain ratio.

The total offset of the closed-loop circuit is:

$$V_{OS(TOTAL)} = V_{IOS} \pm V_{OOS} \frac{A_{CL}}{A_{OL}} \quad (12)$$

where: V_{IOS} = input offset voltage.

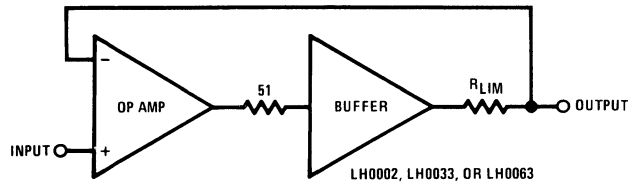
V_{OOS} = buffer offset voltage.

Slew Rate

Slew rate is the rate of change of output voltage for large-signal step input changes. For resistive load, slew rate is limited by internal circuit capacitance and operating current. *Figure 23* shows the slew capabilities of the buffers under large-signal input conditions.

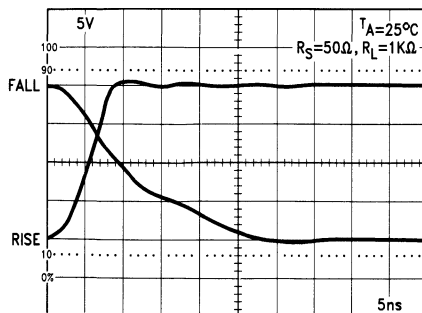
However, when driving capacitive load, the slew rate may be limited by available peak output current according to the following expression.

$$dv/dt = I_{pk}/C_L \quad (13)$$



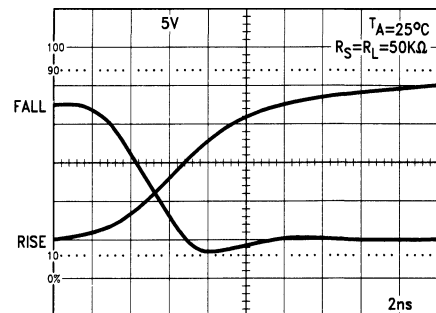
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FIGURE 22. Current Limiting Inside an Amplifier/Buffer Loop



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a. LH0033 Slew Response

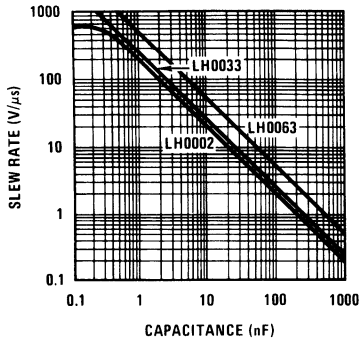


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b. LH0063 Slew Response

FIGURE 23. Positive and Negative Slew of Each Buffer

Note that the peak current available to the load decreases as C_L changes [see equation (2)]. Figure 24 illustrates the effect of the load capacitance on slew rate for the three buffers. Slew rate tests are specified for resistance and/or very small capacitance load, otherwise the slew rate test would be a measure of the available output current. For highest slew rate, it is obvious that stray load capacitance should be minimized.



TL/H/8725-37

FIGURE 24. Slew Rate vs Load Capacitance

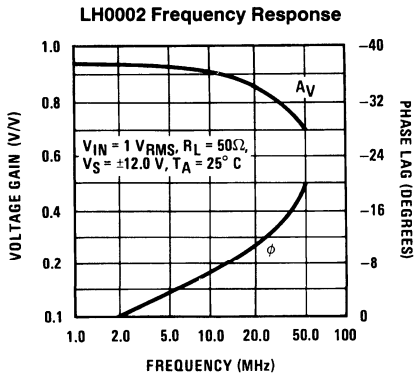
Distortion

The output stage of the three buffer amplifiers are biased at 1 mA to 10 mA to remove any possibility of crossover

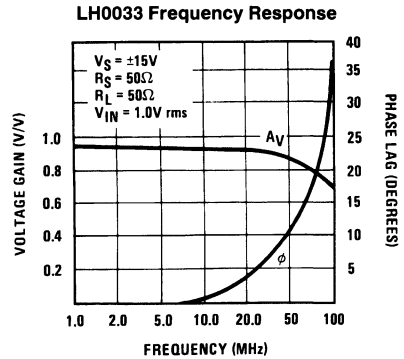
distortion. The LH0063 may exhibit a small amount of crossover distortion in some circumstances due to the relatively low 1 mA output stage bias. The heavy local feedback inherent in emitter-follower or source-follower operation provides a very low distortion output. The remaining distortion (<0.1%) is primarily due to the modulation effect of non-constant V_{CE} as the output voltage changes.

Closed-Loop Feedback Operation

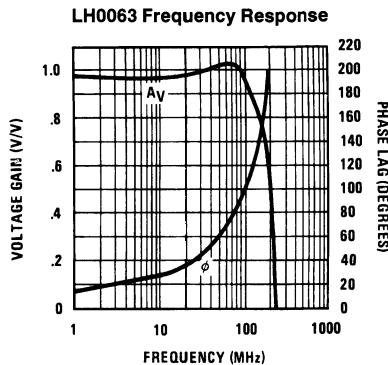
Any of the buffer amplifiers may be used inside an op amp feedback loop. When this is done, the additional phase lag introduced by the buffer must be included in loop stability consideration. With most op amps, the bandwidth of these buffers is so great that the op amp totally controls the loop stability. However, when using very wide-band op amps such as the LH0024, LH0032, and LH0062, the small additional phase lag of the buffers should be taken into consideration. Figure 25 presents the Bode plots of gain and phase for the three buffers. The phase margin and open loop frequency response is altered by the additional pole(s) contributed by the buffer. The buffer phase shift is algebraically summed with the op amp phase shift, and may cause a stable op amp loop to become marginally stable depending upon the relative positions of the op amp and buffer poles. In general, the buffer bandwidth should significantly exceed that of the op amp, so that the loop performance will be determined solely by the op amp.



TL/H/8725-38



TL/H/8725-39



TL/H/8725-40

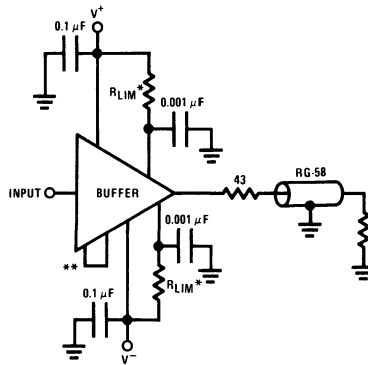
FIGURE 25. Phase-Gain Relationships of Buffers

III. APPLICATIONS CIRCUITS

Because of their high current drive capability, the LH0002, LH0033 and LH0063 buffer amplifiers are suitable for driving terminated or unterminated coaxial cables, and high current or reactive loads. Current limiting resistors should be used to protect the device from excessive peak load currents or accidental short circuit. There is no current limiting built into the devices other than that imposed by the limited beta of the output transistors. *Figure 26* shows a coaxial cable drive circuit. The 43Ω resistor matches the driving source to the cable; however, its inclusion will rarely result in visible improvement in pulse response into a terminated cable. If the 43Ω resistor is included, the output voltage to the

load is about half what it would be without the near end termination.

The LH0033 and LH0063 are useful in high speed sample-and-hold or peak detector circuits because of their very high speed and low-bias-current FET input stages. The high speed peak detector circuit shown in *Figure 27* could be changed to a sample-and-hold circuit simply by removing the detector diode and the reset circuitry. For best accuracy, the circuit offset may be trimmed with the 10 kΩ offset adjustment pot shown. The circuit has a typical acquisition time of 900 ns, to 0.1% of final value for 10V input step signal, and a droop rate of 100 μV/ms. Even faster acquisition time can be achieved by reducing the hold capacitor value.



*For: LH0002, R_{LIM} = 100Ω, 1W
 LH0033, R_{LIM} = 100Ω, 1W
 LH0063, R_{LIM} = 60Ω, 5W
 **Jumper for LH0033 and LH0063 only.

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FIGURE 26. Coaxial Cable Drive Circuit

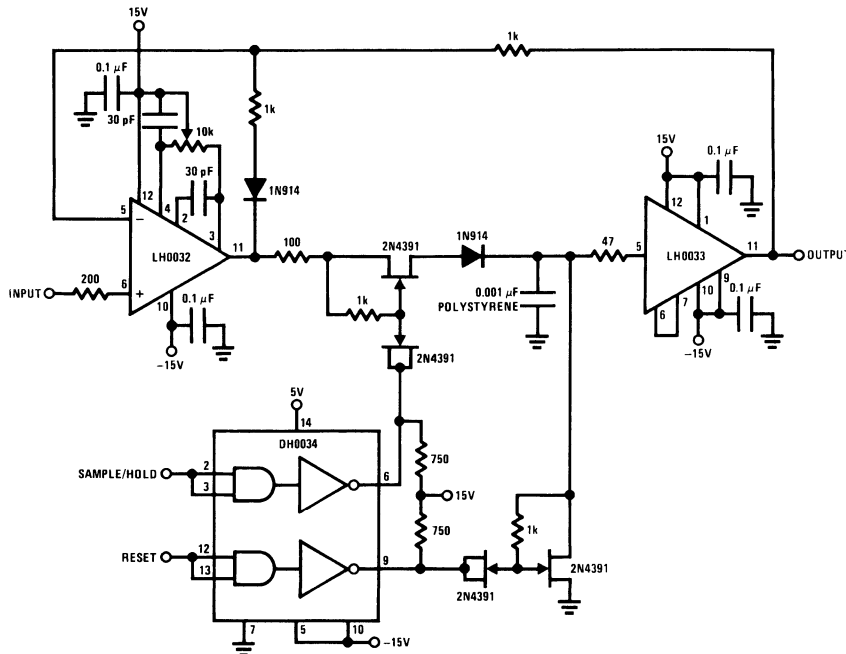


FIGURE 27. High Speed Peak Detector with Hold and Reset Controls

TL/H/8725-42

The LH0033 may be used as a cable-shield driver as shown in *Figure 28*. The advantage is that the source driver is not required to charge the line capacitance of the unterminated coaxial cable, and indeed does not need to match its line impedance; therefore, high speed data transmission is permitted.

The buffers may be used with a single supply without special considerations. A typical application is shown in *Figure 29*. The input is DC biased to mid-operating point and is AC coupled. Its input impedance is approximately 500 k Ω at low frequencies. Note that for DC loads referenced to ground, the quiescent current is increased by the load current set at the input DC bias voltage.

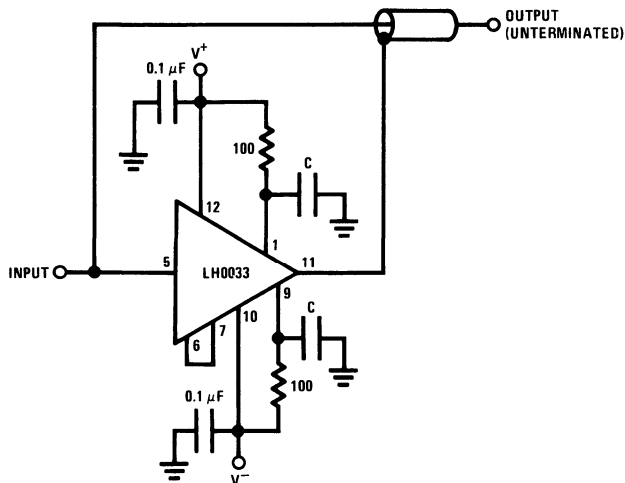


FIGURE 28. High Speed Shield/Line Driver

TL/H/8725-43

The high input impedance of the LH0033 and LH0063 are suitable for active filter applications. A basic two pole, high pass filter is diagrammed in *Figure 30* using the LH0033. The circuit provides a 10 MHz cutoff frequency. One consideration of the filter is its apparent gain change due to the finite output impedance of the amplifier, which affects the overall gain and the damping factor of the filter stage. Resistor R3 ensures that the input capacitance of the amplifier does not interact with the filter response at the frequency of interest.

An equivalent low pass filter is similarly obtained by capacitance and resistance transformation.

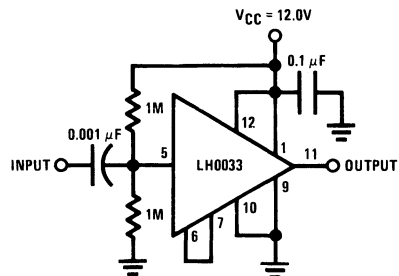


FIGURE 29. Single Supply AC Buffer Amplifier

TL/H/8725-44

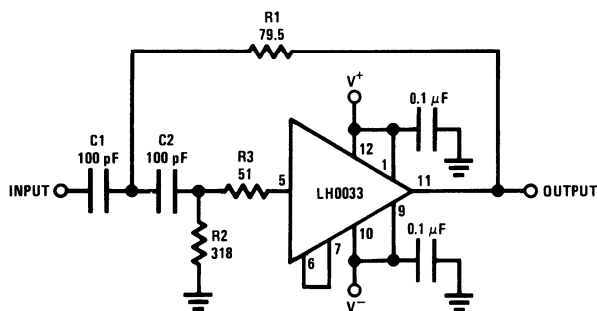


FIGURE 30. Wide Band Two Pole High Pass Filter

TL/H/8725-45

Another filter application is that of a high frequency notch filter, as shown in *Figure 31*. It takes advantage of the buffer's very high slewing capability. Component value sensitivity is extremely critical, as are temperature coefficients and matching of the components. Best performance is attained with perfectly matched components and when the gain of the amplifier is unity. To illustrate, the quality factor Q is very high as amplifier gain approaches 1 with all components matched (in fact, theoretically it approaches ∞) but decreases to about 12.5 with the amplifier gain at 0.98.

The most common use of the buffers is inside an op amp feedback loop as shown in *Figure 32*. The chart in the

figure shows the ideal match of the buffer family to most popular operational amplifiers.

REFERENCES

George S. Moschytz, "Linear Integrated Networks Design," Ch. 3, Active Filter Building Blocks.

"Application of the LH0002 Current Amplifier," National Semiconductor Corporation, AN-13, September 1968.

B. Siegel and L. Van Der Gaag, "Applications For a New Ultra-High Speed Buffer," National Semiconductor Corporation, AN-48, August 1971.

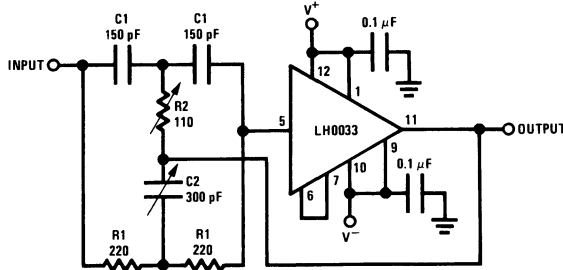
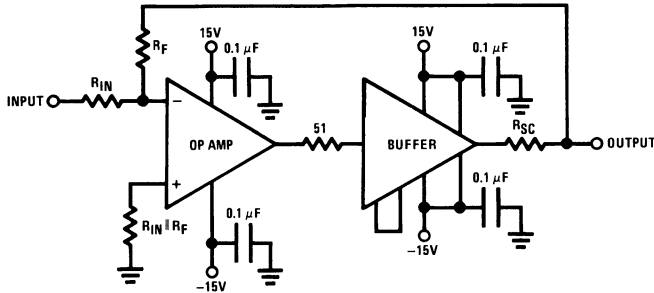


FIGURE 31. 4.5 MHz Notch Filter

TL/H/8725-46



Op Amp

- LM101, LM108, LM741, LF151
- LH0022, LH0042, LH0052
- LF155, LF156, LF157, LH0024, LH0032
- LH0024, LH0032

Recommended Buffer

- LH0002
- LH0033
- LH0063

$$R_{SC} \frac{V_S}{I_{SC}}$$

FIGURE 32. Using Voltage Follower as Output Buffer

TL/H/8725-47

The A/D Easily Allows Many Unusual Applications

National Semiconductor
Application Note 233



AN-233

Accommodation of Arbitrary Analog Inputs

Two design features of the ADC0801 series of A/D converters provide for easy solutions to many system design problems. The combination of differential analog voltage inputs and a voltage reference input which can range from near zero to $5V_{DC}$ are key to these application advantages.

In many systems the analog signal which has to be converted does not range clear to ground ($0.00 V_{DC}$) nor does it reach up to the full supply or reference voltage value. This presents two problems: 1) a "zero-offset" provision is needed—and this may be volts, instead of the few millivolts which are usually provided; and 2) the "full scale" needs to be adjusted to accommodate this reduced span. ("Span" is the actual range of the analog input signal, from $V_{IN\ MIN}$ to $V_{IN\ MAX}$.) This is easily handled with the converter as shown in *Figure 1*.

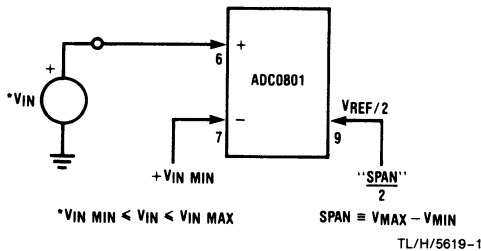


FIGURE 1. Providing Arbitrary Zero and Span Accommodation

TL/H/5619-1

Note that when the input signal, V_{IN} , equals $V_{IN\ MIN}$ the "differential input" to the A/D is zero volts and therefore a digital output code of zero is obtained. When V_{IN} equals $V_{IN\ MAX}$, the "differential input" to the A/D is equal to the "span" (for reference applications convenience, there is an internal gain of two to the voltage which is applied to pin 9, the $V_{REF}/2$ input), therefore the A/D will provide a digital full scale. In this way a wide range of analog input voltages can be easily accommodated.

An example of the usefulness of this feature is when operating with ratiometric transducers which do not output the complete supply voltage range. Some, for example, may output 15% of the supply voltage for a zero reading and 85% of the supply for a full scale reading. For this case, 15% of the supply should be applied to the $V_{IN(-)}$ pin and the $V_{REF}/2$ pin should be biased at one-half of the span, which is $\frac{1}{2}(85\% - 15\%)$ or 35% of the supply. This properly shifts the zero and adjusts the full scale for this application. The $V_{IN(-)}$ input can be provided by a resistive divider which is driven by the power supply voltage and the $V_{REF}/2$ pin should be driven by an op amp. This op amp can be a unity-gain voltage follower which also obtains an input voltage from a resistive divider. These can be combined as shown in *Figure 2*.

This application can allow obtaining the resolution of a greater than 8-bit A/D. For example, 9-bit performance with the 8-bit converter is possible if the span of the analog input voltage should only use one-half of the available 0V to 5V span. This would be a span of approximately 2.5V which could start anywhere over the range of 0V to $2.5V_{DC}$.

The RC network on the output of the op amp of *Figure 2* is used to isolate the transient displacement current demands of the $V_{REF}/2$ input from the op amp.

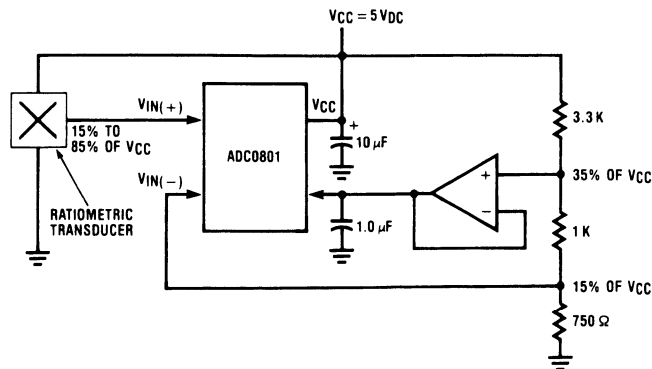


FIGURE 2. Operating with a Ratiometric Transducer which Outputs 15% to 85% of V_{CC}

TL/H/5619-2

Limits of $V_{REF}/2$ Voltage Magnitude

A question arises as to how small in value the span can be made. An ADC0801 part is shown in *Figure 3* where the $V_{REF}/2$ voltage is reduced in steps: from A), 2.5V (for a full scale reading of 5V); to B), 0.625V (for a full scale reading of 1.25V—this corresponds to the resolution of a 10-bit converter over this restricted range); to C), 0.15625V (for a full scale reading of 0.3125V—which corresponds to the resolution of a 12-bit converter). Note that at 12 bits the linearity error has increased to $\frac{1}{2}$ LSB.

For these reduced reference applications the offset voltage of the A/D has to be adjusted as the voltage value of the LSB changes from 20 mV to 5 mV and finally to 1.25 mV as we go from A) to B) to C). This offset adjustment is easily combined with the setting of the $V_{IN\ MIN}$ value at the $V_{IN(-)}$ pin.

Operation with reduced $V_{REF}/2$ voltages increases the requirement for good initial tolerance of the reference voltage (or requires an adjustment) and also the allowed changes in the $V_{REF}/2$ voltage over temperature are reduced.

An interesting application of this reduced reference feature is to directly digitize the forward voltage drop of a silicon diode as a simple digital temperature sensor.

A 10-Bit Application

This analog flexibility can be used to increase the resolution of the 8-bit converter to 10 bits. The heart of the idea is shown in *Figure 4*. The two extra bits are provided by the 2-bit external DAC (resistor string) and the analog switch, SW1.

Note that the $V_{REF}/2$ pin of the converter is supplied with $\frac{1}{8} V_{REF}$ so each of the four spans which are encoded will be:

$$2 \times \frac{1}{8} V_{REF} = \frac{1}{4} V_{REF}$$

In actual implementation of this circuit, the switch would be replaced by an analog multiplexer (such as the CD4066 quad bilateral switch) and a microprocessor would be programmed to do a binary search for the two MS bits. These two bits plus the 8 LSBs provided by the A/D give the 10-bit data. For a particular ladder application, this basic idea can be simplified to a 1-bit ladder to cover a particular range of analog input voltages with increased resolution. Further, there may exit *a priori* knowledge by the CPU which could locate the analog signal to within the 1 or 2 MSBs without requiring a search algorithm.

A Microprocessor Controlled Voltage Comparator

In applications where set points (or "pick points") are set up by analog voltages, the A/D can be used as a comparator to determine whether an analog input is greater than or less than a reference DC value. This is accomplished by simply grounding the $V_{REF}/2$ pin (to provide maximum resolution) and applying the reference DC value to the $V_{IN(-)}$ input. Now with the analog signal applied to the $V_{IN(+)}$ input, an all zeros code will be output for $V_{IN(+)}$ less than the reference voltage and an all ones code for $V_{IN(+)}$ greater

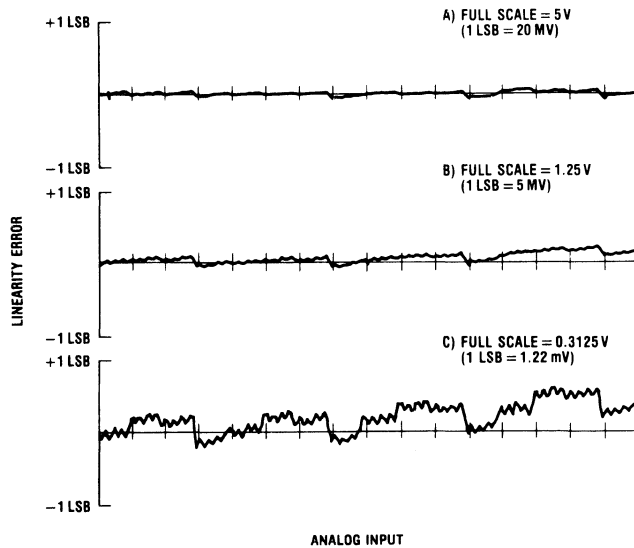


FIGURE 3. Linearity Error for Reduced Analog Input Spans

TL/H/5619-3

than the reference voltage. This reduces the computational loading of the CPU. Further, using analog switches, a single A/D can encode some analog input channels in the "normal" way and can provide this comparator operation, under microprocessor control, for other analog input channels.

DACs Multiply and A/Ds Divide

Computation can be directly done with converter components to either increase the speed or reduce the loading on a CPU. It is rather well known that DACs multiply—and for this reason many are actually called "MDACs" to signify "multiplying DAC." An analog product voltage is provided as an output signal from a DAC for a hybrid pair of input signals—one is analog (the V_{REF} input) and the other is digital.

The A/D provides a digital quotient output for two analog input signals. The numerator or the dividend is the normal analog input voltage to the A/D and the denominator or the divisor is the V_{REF} input voltage.

High speed computation can be provided external to the CPU by either or both of these converter products. DACs are available which provide 4-quadrant multiplications (the MDACs and MICRO-DACs™), but A/Ds are usually limited to only one quadrant.

Combine Analog Self-Test with Your Digital Routines

A new innovation is the digital self-test and diagnostic routines which are being used in equipment. If an 8-bit A/D converter and an analog multiplexer are added, these testing routines can then check all power supply voltage levels and other set point values in the system. This is a major application area for the new generation converter products.

Control Temperature Coefficients with Converters

The performance of many systems can be improved if voltages within the system can be caused to change properly with changes in ambient temperature. This can be accomplished by making use of low cost 8-bit digital to analog converters (DACs) which are used to introduce a "dither" or small change about the normal operating values of DC power supplies or other voltages within the system. Now, a single measurement of the ambient temperature and one A/D converter with a MUX can be used by the microprocessor to establish proper voltage values for a given ambient temperature. This approach easily provides non-linear temperature compensation and generally reduces the cost and improves the performance of the complete system.

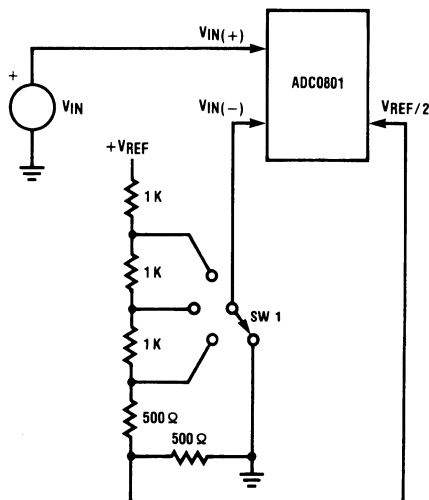


FIGURE 4. 10-Bit A/D Using the 8-Bit ADC0801

TL/H/5619-4

Save an Op Amp

In applications where an analog signal voltage which is to be converted may only range from, for example, $0V_{DC}$ to 500 mV_{DC} , an op amp with a closed-loop gain of 10 is required to allow making use of the full dynamic range ($0V_{DC}$ to $5V_{DC}$) of the A/D converter. An alternative circuit approach is shown in *Figure 5*. Here we, instead, attenuate the magnitude of the reference voltage by 10:1 and apply the 0 to 500 mV signal directly to the A/D converter. The $V_{IN(-)}$ input is now used for a V_{OS} adjust, and due to the "sampled-data" operation of the A/D there is essentially no V_{OS} drift with temperature changes.

As shown in *Figure 5*, all zeros will be output by the A/D for an input voltage (at the $V_{IN(+)}$ input) of $0V_{DC}$ and all ones will be output by the A/D for a 500 mV_{DC} input signal. Operation of the A/D in this high sensitivity mode can be useful in many low cost system applications.

Digitizing a Current Flow

In system applications there are many requirements to monitor the current drawn by a PC card or a high current load device. This typically is done by sampling the load current flow with a small valued resistor. Unfortunately, it is usually desired that this resistor be placed in series with the V_{CC} line. The problem is to remove the large common-mode DC voltage, amplify the differential signal, and then present the ground referenced voltage to an A/D converter.

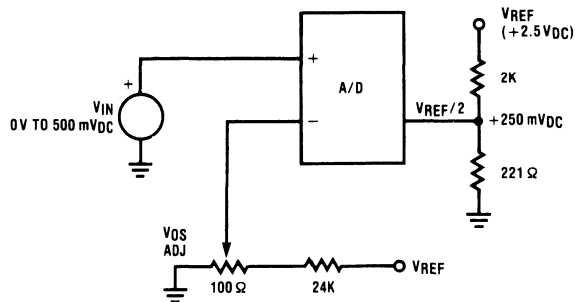


FIGURE 5. Directly Encoding a Low Level Signal

All of these functions can be handled by the A/D using the circuit shown in *Figure 6*. Here we are making use of the differential input feature and the common-mode rejection of the A/D to directly encode the voltage drop across the load current sampling resistor. An offset voltage adjustment is provided and the $V_{REF}/2$ voltage is reduced to 50 mV to accommodate the input voltage span of 100 mV. If desired, a multiplexer can be used to allow switching the $V_{IN(-)}$ input among many loads.

Conclusions

At first glance it may appear that the A/D converters were mainly designed for an easy digital interface to the micro-processor. This is true, but the analog interface has also been given attention in the design and a very useful converter product has resulted from this combination of features.

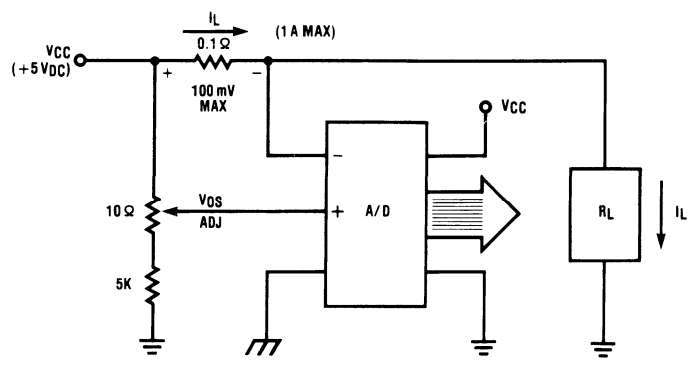


FIGURE 6. Digitizing a Current Flow

TL/H/5619-5

An Introduction to the Sampling Theorem

National Semiconductor
Application Note 236



An Introduction to the Sampling Theorem

With rapid advancement in data acquisition technology (i.e. analog-to-digital and digital-to-analog converters) and the explosive introduction of micro-computers, selected complex linear and nonlinear functions currently implemented with analog circuitry are being alternately implemented with sample data systems.

Though more costly than their analog counterpart, these sampled data systems feature programmability. Additionally, many of the algorithms employed are a result of developments made in the area of signal processing and are in some cases capable of functions unrealizable by current analog techniques.

With increased usage a proportional demand has evolved to understand the theoretical basis required in interfacing these sampled data systems to the analog world.

This article attempts to address the demand by presenting the concepts of aliasing and the sampling theorem in a manner, hopefully, easily understood by those making their first attempt at signal processing. Additionally discussed are some of the unobvious hardware effects that one might encounter when applying the sampled theorem.

With this . . . let us begin.

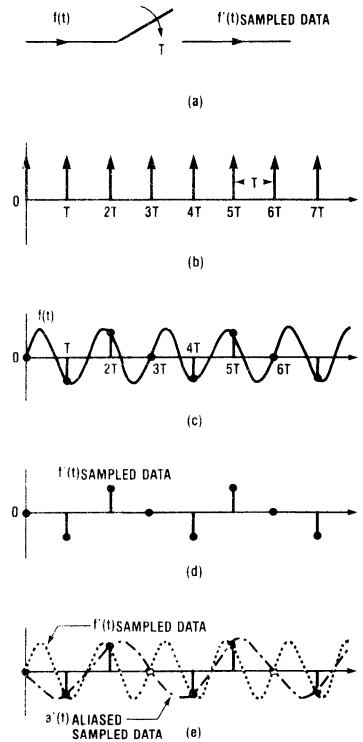
I. An Intuitive Development

The sampling theorem by C.E. Shannon in 1949 places restrictions on the frequency content of the time function signal, $f(t)$, and can be simply stated as follows:

In order to recover the signal function $f(t)$ exactly, it is necessary to sample $f(t)$ at a rate greater than twice its highest frequency component.

Practically speaking for example, to sample an analog signal having a maximum frequency of 2Kc requires sampling at greater than 4Kc to preserve and recover the waveform exactly.

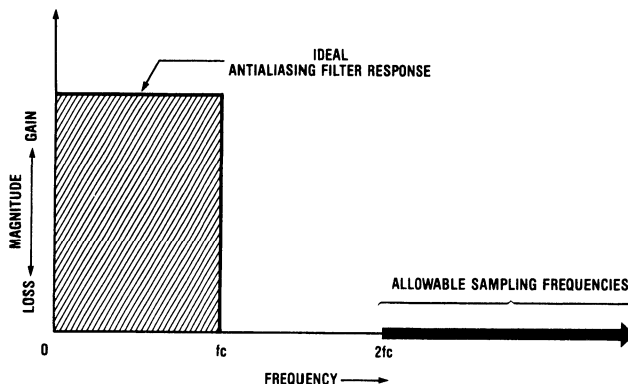
The consequences of sampling a signal at a rate below its highest frequency component results in a phenomenon known as *aliasing*. This concept results in a frequency mistakenly taking on the identity of an entirely different frequency when recovered. In an attempt to clarify this, envision the ideal sampler of Figure 1(a), with a sample period of T shown in (b), sampling the waveform $f(t)$ as pictured in (c). The sampled data points of $f'(t)$ are shown in (d) and can be defined as the sample set of the continuous function $f(t)$. Note in Figure 1(e) that another frequency component, $a'(t)$, can be found that has the same sample set of data points as $f'(t)$ in (d). Because of this it is difficult to determine which frequency $a'(t)$, is truly being observed. This effect is similar to that observed in western movies when watching the



TL/H/5620-1

FIGURE 1. When sampling, many signals may be found to have the same set of data points. These are called aliases of each other.

spoked wheels of a rapidly moving stagecoach rotate backwards at a slow rate. The effect is a result of each individual frame of film resembling a discrete strobed sampling operation flashing at a rate slightly faster than that of the rotating wheel. Each observed sample point or frame catches the spoked wheel slightly displaced from its previous position giving the effective appearance of a wheel rotating backwards. Again, aliasing is evidenced and in this example it becomes difficult to determine which is the true rotational frequency being observed.



TL/H/5620-2

FIGURE 2. Shown in the shaded area is an ideal, low pass, anti-aliasing filter response. Signals passed through the filter are bandlimited to frequencies no greater than the cutoff frequency, f_c . In accordance with the sampling theorem, to recover the bandlimited signal exactly the sampling rate must be chosen to be greater than $2f_c$.

On the surface it is easily said that anti-aliasing designs can be achieved by sampling at a rate greater than twice the maximum frequency found within the signal to be sampled. In the real world, however, most signals contain the entire spectrum of frequency components; from the desired to those present in white noise. To recover such information accurately the system would require an unrealizably high sample rate.

This difficulty can be easily overcome by preconditioning the input signal, the means of which would be a band-limiting or frequency filtering function performed prior to the sample data input. The prefilter, typically called anti-aliasing filter guarantees, for example in the low pass filter case, that the sampled data system receives analog signals having a spectral content no greater than those frequencies allowed by the filter. As illustrated in *Figure 2*, it thus becomes a simple matter to sample at greater than twice the maximum frequency content of a given signal.

A parallel analog of band-limiting can be made to the world of perception when considering the spectrum of white light. It can be realized that the study of violet light wavelengths generated from a white light source would be vastly simplified if initial band-limiting were performed through the use of a prism or white light filter.

II. The Sampling Theorem

To solidify some of the intuitive thoughts presented in the previous section, the sampling theorem will be presented applying the rigor of mathematics supported by an illustrative proof. This should hopefully leave the reader with a comfortable understanding of the sampling theorem.

Theorem: If the Fourier transform $F(\omega)$ of a signal function $f(t)$ is zero for all frequencies above $|\omega| \geq \omega_c$, then $f(t)$ can be uniquely determined from its sampled values

$$f_n = f(nT) \quad (1)$$

These values are a sequence of equidistant sample points spaced $\frac{1}{2fc} = \frac{T_c}{2} = T$ apart. $f(t)$ is thus given by

$$f(t) = \sum_{n=-\infty}^{\infty} f(nT) \frac{\sin \omega_c (t - nT)}{\omega_c (t - nT)} \quad (2)$$

Proof: Using the inverse Fourier transform formula:

$$f(t) = \frac{1}{2\pi} \int_{-\infty}^{\infty} F(\omega) \epsilon^{j\omega t} d\omega \quad (3)$$

the band limited function, $f(t)$, takes the form, *Figure 3a*,

$$f(t) = \frac{1}{2\pi} \int_{-\omega_c}^{\omega_c} F(\omega) \epsilon^{j\omega t} d\omega \quad (4)$$

$$f_n = f\left(n \frac{\pi}{\omega_c}\right) \text{ is then given as}$$

$$f_n = \frac{1}{2\pi} \int_{-\omega_c}^{\omega_c} F(\omega) \epsilon^{j\omega \frac{n\pi}{\omega_c}} d\omega \quad (5)$$

See *Figure 3c* and *e*.

Expressing $F(\omega)$ as a Fourier series in the interval $-\omega_c \leq \omega \leq \omega_c$ we have

$$F(\omega) = \sum_{n=-\infty}^{\infty} C_n \epsilon^{-j\omega \frac{n\pi}{\omega_c}} \quad (6)$$

Where,

$$C_n = \frac{1}{2\omega_c} \int_{-\omega_c}^{\omega_c} F(\omega) \epsilon^{j\omega \frac{n\pi}{\omega_c}} d\omega \quad (7)$$

Further manipulating eq. (7)

$$C_n = \frac{2\pi}{2\omega_c} \frac{1}{2\pi} \int_{-\omega_c}^{\omega_c} F(\omega) \epsilon^{j\omega \frac{n\pi}{\omega_c}} d\omega \quad (8)$$

C_n can be written as

$$C_n = \frac{\pi}{\omega_c} f_n \quad (9)$$

Substituting eq. (9) into eq. (6) gives the periodic Fourier Transform

$$F_p(\omega) = \sum_{n=-\infty}^{\infty} \frac{\pi}{\omega_c} f_n \epsilon^{-j\omega \frac{n\pi}{\omega_c}} \quad (10)$$

of Figure 3f. Using Poisson's sum formula¹ $F(\omega)$ can be stated more clearly as

$$F(\omega) = \sum_{n=-\infty}^{\infty} F(\omega - 2n\omega_c) \quad (11)$$

Interestingly for the interval $-\omega_c \leq \omega \leq \omega_c$ the periodic function $F_p(\omega)$ and Figure 3f. equals $F(\omega)$ and Figure 3b. respectively. Analogously if $F_p(\omega)$ were multiplied by a rectangular pulse defined,

$$H(\omega) = 1 \quad -\omega_c \leq \omega \leq \omega_c \quad (12)$$

and

$$H(\omega) = 0 \quad |\omega| \geq \omega_c \quad (13)$$

then as pictured in Figures 4b, d, and f,

$$F(\omega) = H(\omega) \bullet F_p(\omega) = H(\omega) \sum_{n=-\infty}^{\infty} \frac{\pi}{\omega_c} f_n \epsilon^{-j\omega \frac{n\pi}{\omega_c}} \quad (14)$$

Solving for $f(t)$ the inverse Fourier transform eq (3) is applied to eq (14)

$$\begin{aligned} f(t) &= \frac{1}{2\pi} \int_{-\omega_c}^{\omega_c} F(\omega) \epsilon^{j\omega t} d\omega \quad (3) \\ &= \frac{1}{2\pi} \int_{-\omega_c}^{\omega_c} \left[H(\omega) \sum_{n=-\infty}^{\infty} \frac{\pi}{\omega_c} f_n \epsilon^{-j\omega \frac{n\pi}{\omega_c}} \right] \epsilon^{j\omega t} d\omega \\ &= \sum_{n=-\infty}^{\infty} f_n \frac{1}{2\omega_c} \int_{-\omega_c}^{\omega_c} \epsilon^{j\omega \left(t - \frac{n\pi}{\omega_c} \right)} d\omega \end{aligned}$$

¹Poisson's sum formula

$$\frac{1}{T} \sum_{n=-\infty}^{\infty} F(\omega - n\omega_s) = \sum_{n=-\infty}^{\infty} f(nT) \epsilon^{-j\omega nT}$$

where $T = \frac{1}{f_s}$ and f_s is the sampling frequency

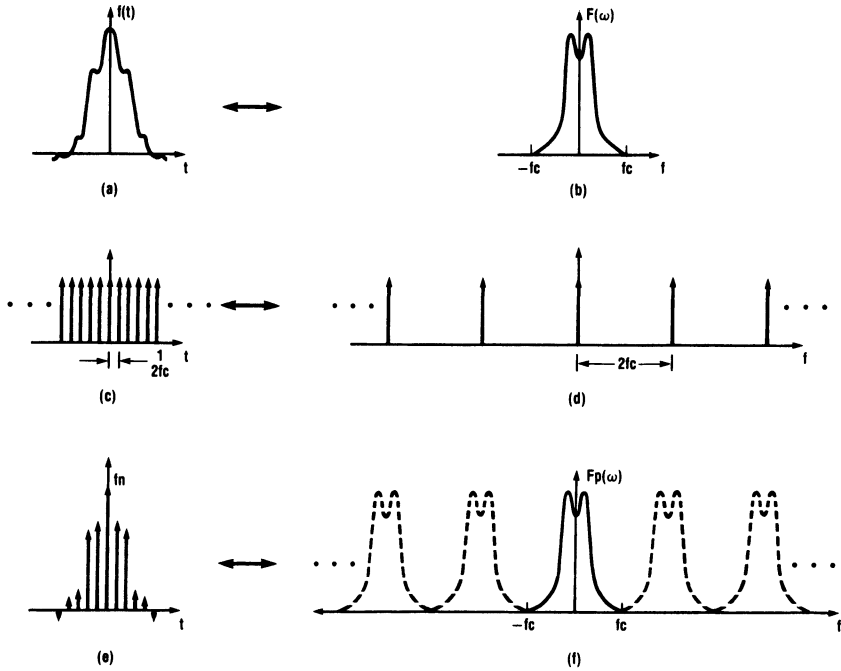


FIGURE 3. Fourier transform of a sampled signal.

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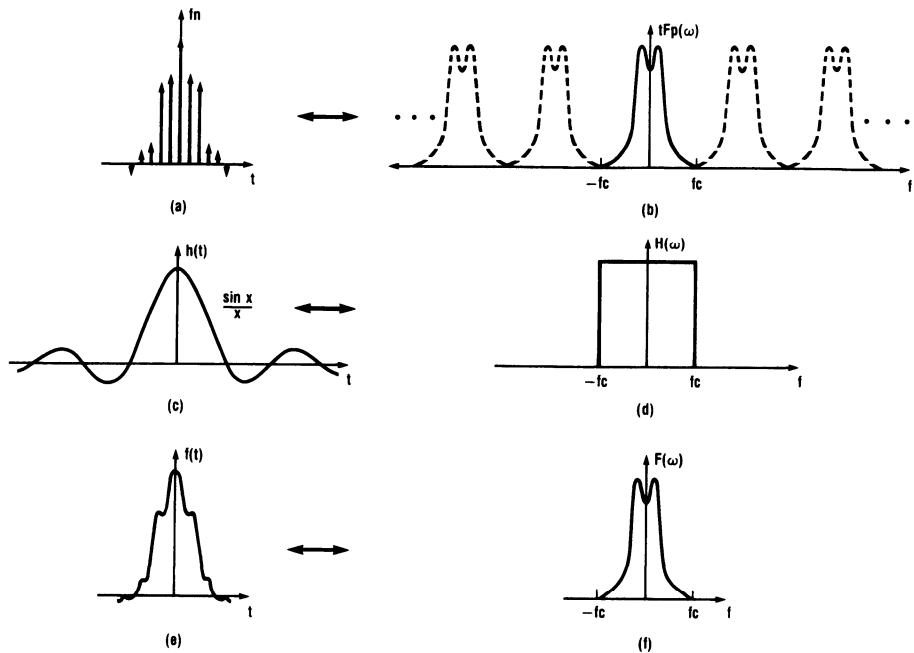


FIGURE 4. Recovery of a signal $f(t)$ from sampled data information.

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giving

$$f(t) = \sum_{n=-\infty}^{\infty} f_n \frac{\sin \omega_c \left(t - \frac{n\pi}{\omega_c} \right)}{\omega_c \left(t - \frac{n\pi}{\omega_c} \right)} \quad (15)$$

Eq (15) is equivalent to eq (2) as is illustrated in Figure 4e and Figure 3a respectively.

As observed in Figures 3 and 4, each step of the sampling theorem proof was also illustrated with its Fourier transform pair. This was done to present alternate illustrative proofs.

Recalling the convolution² theorem, the convolution of $F(\omega)$, Figure 3b, with a set of equidistant impulses, Figure 3d, yields the same periodic frequency function $F_p(\omega)$, Figure 3f, as did the Fourier transform of f_n , Figure 3e, the product of $f(t)$, Figure 3a, and its equidistant sample impulses, Figure 3c.

In the same light the original time function $f(t)$, Figure 4e, could have been recovered from its sampled waveform by convolving f_n , Figure 4a, with $h(t)$, Figure 4c, rather than multiplying $F_p(\omega)$, Figure 4b, by the rectangular function $H(\omega)$, Figure 4d, to get $F(\omega)$, Figure 4f, and finally inverse transforming to achieve $f(t)$, Figure 4e, as done in the mathematic proof.

III. Some Observations and Definitions

If Figures 3f or 4b are re-examined it can be noted that the original spectrum $F_p(\omega)$, $|\omega| \leq \omega_c$, and its images $F_p(\omega)$,

$|\omega| \geq \omega_c$, are non-overlapping. On the other hand Figure 5 illustrates spectral folding, overlapping or aliasing of the spectrum images into the original signal spectrum. This aliasing effect is, in fact, a result of undersampling and further causes the information of the original signal to be indistinguishable from its images (i.e. Figure 1e). From Figure 6 one can readily see that the signal is thus considered non-recoverable.

The frequency $|fc|$ of Figure 3f and 4b is exactly one half the sampling frequency, $fc = fs/2$, and is defined as the Nyquist frequency (after Harry Nyquist of Bell Laboratories). It is also often called the aliasing frequency or folding frequency for the reasons discussed above. From this we can say that in order to prevent aliasing in a sampled-data system the sampling frequency should be chosen to be greater than twice the highest frequency component f_c of the signal being sampled.

By definition

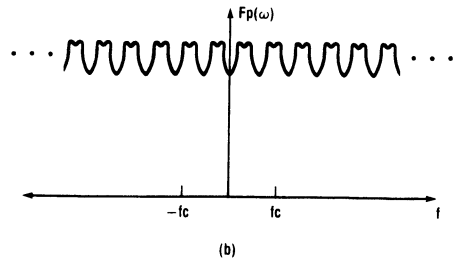
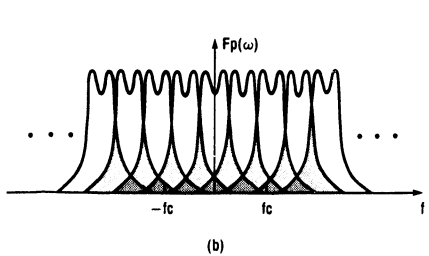
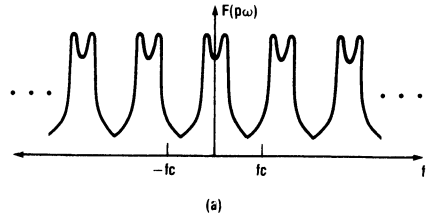
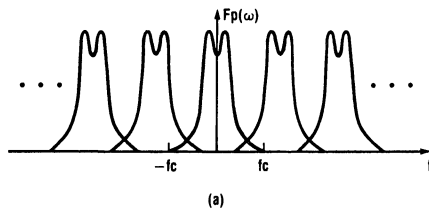
$$f_s \geq 2f_c \quad (16)$$

Note, however, that no mention has been made to sample at precisely the Nyquist rate since in actual practice it is

² The convolution theorem allows one to mathematically convolve in the time domain by simply multiplying in the frequency domain. That is, if $f(t)$ has the Fourier transform $F(\omega)$, and $x(t)$ has the Fourier transform $X(\omega)$, then the convolution $f(t) * x(t)$ has the Fourier transform $F(\omega) * X(\omega)$.

$$f(t) * x(t) \longleftrightarrow F(\omega) * X(\omega)$$

$$f(t) \bullet x(t) \longleftrightarrow F(\omega) \bullet X(\omega)$$

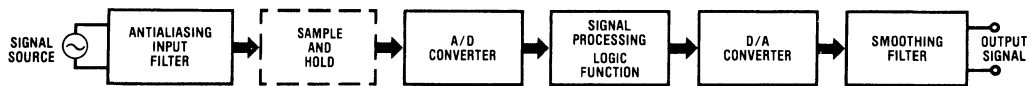


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FIGURE 5. Spectral folding or aliasing caused by:
(a) under sampling
(b) exaggerated under sampling.

FIGURE 6. Aliased spectral envelope (a) and (b) of
Figures 5a and 5b respectively.



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FIGURE 7. Generalized single channel sample data system.

impossible to sample at $f_s = 2f_c$ unless one can guarantee there are absolutely no signal components above f_c . This can only be achieved by filtering the signal prior to sampling with a filter having infinite rolloff . . . a physical impossibility, see *Figure 2*.

IV. The Sampling Theorem and Its Hardware Implications

Though there are numerous sophisticated techniques of implementation, it is appropriate to re-emphasize that the intent of this article is to give the first time user a basic and fundamental approach toward the design of a sampled-data system. The method with which to achieve this goal will be to introduce a few of the common perils encountered when implementing such a system. We begin by considering the generalized block diagram of *Figure 7*.

As shown in *Figure 7*, prior to any signal processing manipulation the analog input signal must be preconditioned to prevent aliasing and thereafter digitized to logic signals usable by the logic function block. The antialiasing and digitizing functions are performed by an input filter and analog-to-digital converter respectively. Once digitized the signal can then be altered or processed and upon completion, reconstructed back to a continuous analog signal via a digital-to-analog converter followed by a smoothing filter.

To this point no mention has been made concerning the sample and hold circuit block depicted in *Figure 7*. In general the analog-to-digital converter can operate as a stand alone unit. In many high speed operations however, the converter speed is insufficient and thus requires the assistance of a sample and hold circuit. This will be discussed in detail further in the article.

A. The Antialiasing Input Filter

As indicated earlier in the text, the antialiasing filter should band-limit the input signal's spectrum to frequencies no greater than the Nyquist frequency. In the real world however, filters are non-ideal and have typical attenuation or band-limiting and phase characteristics as shown in *Figure 8*.³ It must also be realized that true band-limiting of a specific frequency spectrum is not possible. In the sample data system band-limiting is achieved by attenuating those frequencies greater than the Nyquist frequency to a level undetectable or invisible to the system analog-to-digital (A/D) converter. This level would typically be less than the rms quantization⁴ noise level defined by the specific converter being used.

³In order not to disrupt the flow of the discussion a list of filter terms has been presented in Appendix A.

⁴For an explanation of quantization refer to section IV. B. of this article.

As an example of how an antialiasing filter would be applied, assume a sample data system having within it an 8-bit A/D converter. Eight bits translates to $2^n = 2^8 = 256$ levels of resolution. If a 2.56 volt reference were used each quantization level, q , would represent the equivalent of $2.56 \text{ volts} / 256 = 10 \text{ millivolts}$. Realizing this the antialiasing filter would be designed such that frequencies in the stopband were attenuated to less than the rms quantization noise level of $q/2\sqrt{3}$ and thus appearing invisible to the system. More specifically

$$-20 \log_{10} \frac{V \text{ full scale}}{V_q/2\sqrt{3}} \cong -59 \text{ dB} = A_{\text{MIN}}$$

It can be seen, for example in the Butterworth filter case (characterized as having a maximally flat pass-band) of *Figure 9a* that any order of filter may be used to achieve the -59 dB attenuation level, however, the higher the order, the faster the roll off rate and the closer the filter magnitude response will approach the ideal.

Referring back to *Figure 8* it is observed that those frequencies greater than ω_a are not recognized by the A/D converter and thus the sampling frequency of the sample data system would be defined as $\omega_s \geq 2\omega_a$. Additionally, the frequencies present within the filtered input signal would be those less than ω_a . Note however, that the portion of the signal frequencies least distorted are those between $\omega = 0$ and ω_p and those within the transition band are distorted to a substantial degree, though it was originally desired to limit the signal to frequencies less than the cutoff ω_p , because of the non-ideal frequency response the true Nyquist frequency occurred at ω_a . We see then that the sampled-data system could at most be accurate for those frequencies within the antialiasing filter passband.

From the above example, the design of an antialiasing filter appears to be quite straight forward. Recall however, that all waveforms are composed of the sums and differences of various frequency components and as a result, if the response of the filter passband were not flat for the desired signal frequency spectrum, the recovered signal would be an inaccurate summation of all frequency components altered by their relative attenuations in the pass-band.

Additionally the antialiasing filter design should not neglect the effects of delay. As illustrated in *Figure 8* and *9b*, delay time corresponds to a specific phase shift at a particular

frequency. Similar to the flat pass-band consideration, if the phase shift of the filter is not exactly proportional to the frequency, the output of the filter will be a waveform in which the summation of all frequency components has been altered by shifts in their relative phase. *Figure 9b* further indicates that contrary to the roll off rate, the higher the filter order the more non-ideal the delay becomes (increased delay) and the result is a distorted output signal.

A final and complex consideration to understand is the effects of sampling. When a signal is sampled the end effect is the multiplication of the signal by a unit sampling pulse train as recalled from *Figure 3a, c* and *e*. The resultant waveform has a spectrum that is the convolution of the signal spectrum and the spectrum of the unit sample pulse train, i.e. *Figure 3b, d*, and *f*. If the unit sample pulse has the classical $\text{sin } X/X$ spectrum⁵ of a rectangular pulse, see *Figure 13*, then the convolution of the pulse spectrum with the signal spectrum would produce the non-ideal sampled signal spectrum shown in *Figure 10a, b*, and *c*.

It should be realized that because of the band-limiting or filtering and delay response of the $\text{Sin } X/X$ function combined with the effects of the non-ideal antialiasing filter (i.e. non-flat pass-band and phase shift) certain of the sum and difference frequency components may fall within the desired signal spectrum thereby creating aliasing errors, *Figure 10c*.

When designing antialiasing filters it will be found that the closer the filter response approaches the ideal the more complex the filter becomes. Along with this an increase in delay and pass-band ripple combine to distort and alias the input signal. In the final analysis the design will involve trade offs made between filter complexity, sampling speed and thus system bandwidth.

B. The Analog-to-Digital Converter

Following the antialiasing filter is the A/D converter which performs the operations of quantizing and coding the input signal in some finite amount of time. *Figure 11* shows the quantization process of converting a continuous analog input signal into a set of discrete output levels. A quantization, q , is thus defined as the smallest step used in the digital

⁵This will be explained more clearly in Section IV. of this article.

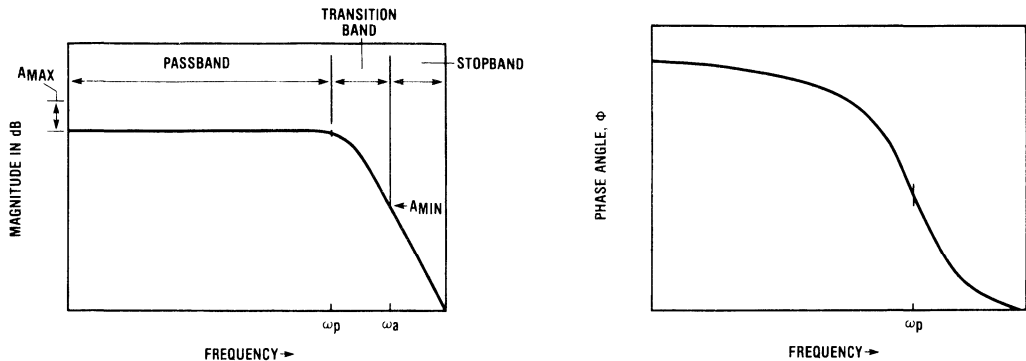
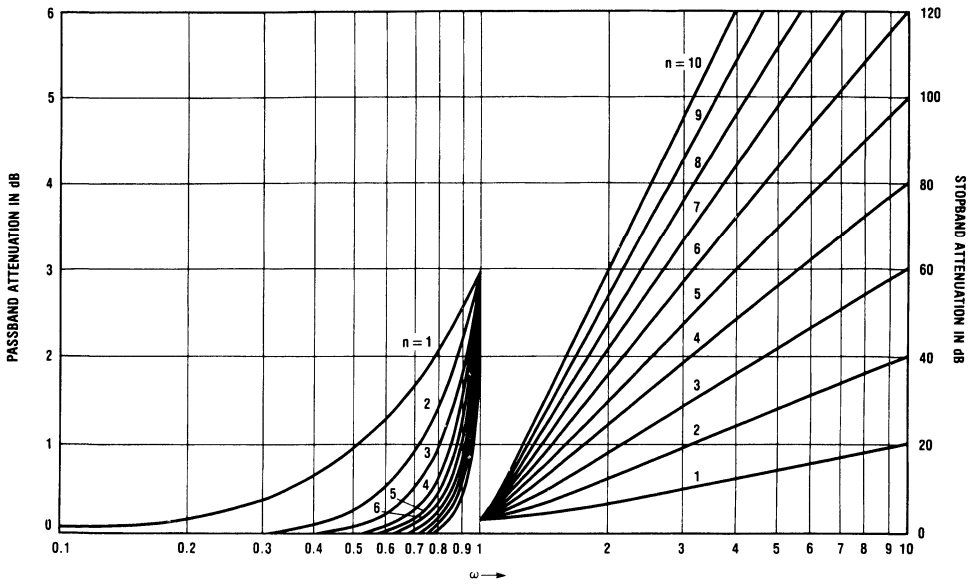


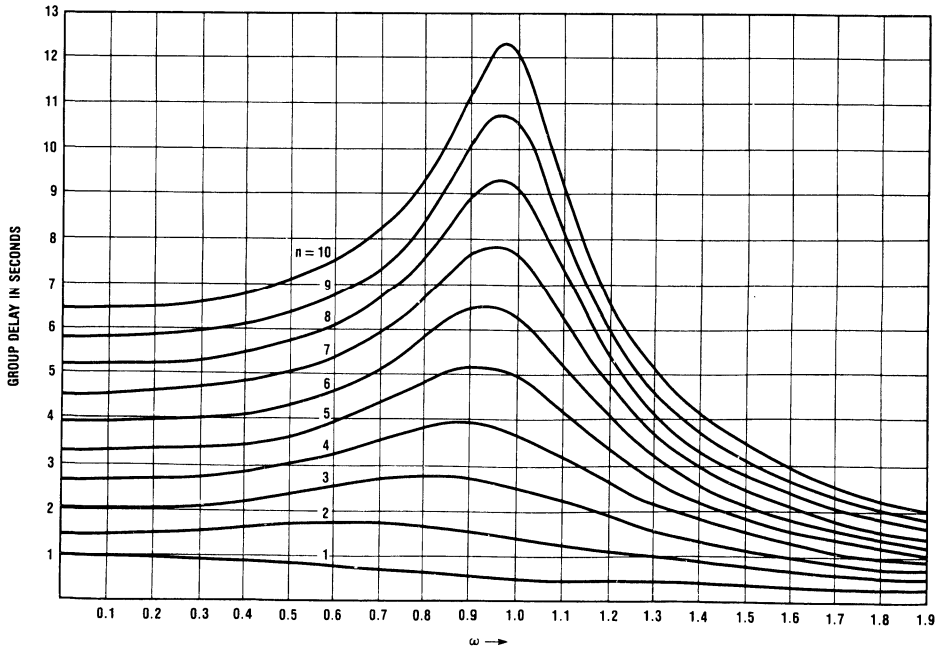
FIGURE 8. Typical filter magnitude and phase versus frequency response.

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a) Attenuation characteristics of a normalized Butterworth filter as a function of degree n .



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b) Group delay performances of normalized Butterworth lowpass filters as a function of degree n .

FIGURE 9

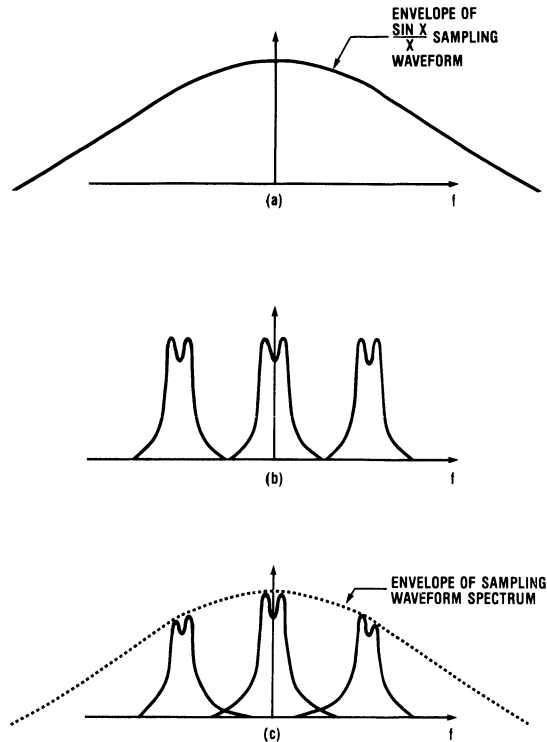


FIGURE 10. (c) equals the convolution of (a) with (b).

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representation of $f_q(n)$ where $f(n)$ is the sample set of an input signal $f(t)$ and is expressed by a finite number of bits giving the sequence $f_q(n)$. Digitally speaking q is the value of the least significant code bit. The difference signal $\epsilon(n)$ shown in Figure 11 is called quantization noise or error and can be defined as $\epsilon(n) = f(n) - f_q(n)$. This error is an irreducible one and is a function of the quantizing process. Its error amplitude is dependent on the number of quantization levels or quantizer resolution and as shown, the maximum quantization error is $|q/2|$.

Generally $\epsilon(n)$ is treated as a random error when described in terms of its probability density function, that is, all values of $\epsilon(n)$ between $q/2$ and $-q/2$ are equally probable, then for the average value $\epsilon(n)_{avg} = 0$ and for the rms value $\epsilon(n)_{rms} = q/2\sqrt{3}$.

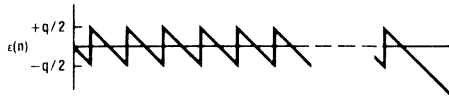
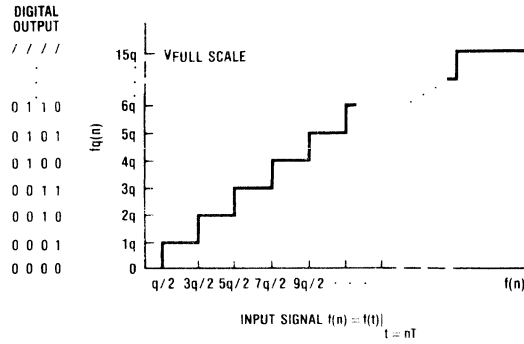
As a side note it is appropriate at this point to emphasize that all analog signals have some form of noise corruption. If for example an input signal has a finite signal-to-noise ratio of 40dB it would be superfluous to select an A/D converter with a high number of bits. It may be realized that the use of a large number of bits does not give the digitized signal a higher signal-to-noise ratio than that of the original analog input signal. As a supportive argument one may say that though the quantization steps q are very small with respect to the peak input signal the lower order bits of the A/D converter merely provide a more accurate representation of the noise inherent in the analog input signal.

Returning to our discussion, we define the conversion time as the time taken by the A/D converter to convert the analog input signal to its equivalent quantization or digital code. The conversion speed required in any particular application depends upon the time variation of the signal to be converted and the amount of resolution or bits, n , required. Though the antialiasing filter helps to control the input signal time rate of change by band-limiting its frequency spectrum, a finite amount of time is still required to make a measurement or conversion. This time is generally called the aperture time and as illustrated in Figure 12 produces amplitude measurement uncertainty errors. The maximum rate of change detectable by an A/D converter can simply be stated as

$$\left. \frac{dv}{dt} \right|_{\text{maximum resolvable rate of change}} = \frac{V \text{ full scale}}{2^n T \text{ conversion time}} \quad (17)$$

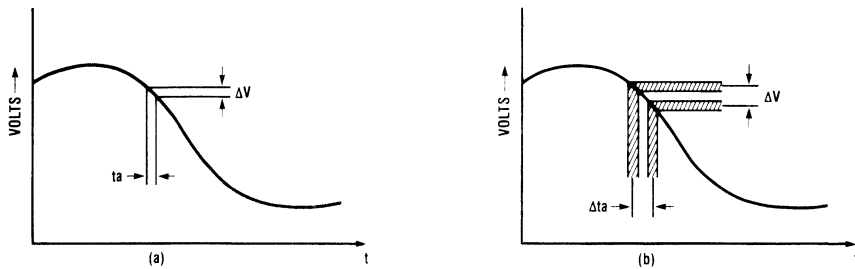
If for example V full scale = 10.24 volts, T conversion time = 10 ms, and $n = 10$ or 1024 bits of resolution then the maximum rate of change resolvable by the A/D converter would be 1 volt/sec. If the input signal has a faster rate of change than 1 volt/sec, 1 LSB changes cannot be resolved within the sampling period.

In many instances a sample-and-hold circuit may be used to reduce the amplitude uncertainty error by measuring the input signal with a smaller aperture time than the conversion time aperture of the A/D converter. In this case the



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FIGURE 11. Quantization error.



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ΔV: AMPLITUDE UNCERTAINTY ERROR

ta: APERTURE TIME

Δta: APERTURE TIME UNCERTAINTY

FIGURE 12. Amplitude uncertainty as a function of (a) a nonvarying aperture and (b) aperture time uncertainty.

maximum rate of change resolvable by the sample-and-hold would be

$$\left. \frac{dv}{dt} \right|_{\text{maximum resolvable rate of change}} = \frac{V \text{ full scale}}{t \text{ aperture}} \quad (18)$$

Note also that the actual calculated rate of change may be limited by the slew rate specification for the sample-and-hold in the track mode. Additionally it is very important to clarify that this does not imply violating the sampling theorem in lieu of the increased ability to more accurately sample signals having a fast time rate of change.

An ideal sample-and-hold effectively takes a sample in zero time and with perfect accuracy holds the value of the sample indefinitely. This type of sampler is also known as a zero order hold circuit and its effect on a sample data system warrants some discussion.

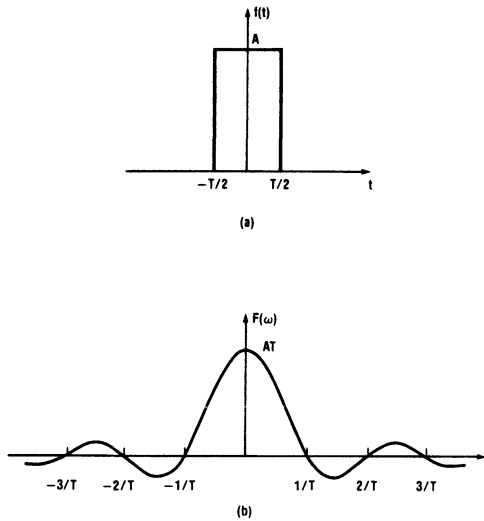
It is appropriate to recall the earlier discussion that the spectrum of a sampled signal is one in which the resultant spectrum is the product obtained by convolving the input signal spectrum with the $\text{sin } X/X$ spectrum of the sampling waveform. Figure 13 illustrates the frequency spectrum plotted from the Fourier transform

$$F(\omega) = AT \frac{\sin \frac{\omega T}{2}}{\frac{\omega T}{2}} \quad (19)$$

of a rectangular pulse. The $\text{sin } X/X$ form occurs frequently in modern communication theory and is commonly called the sampling function.

The magnitude and phase of a typical zero order hold sampler spectrum

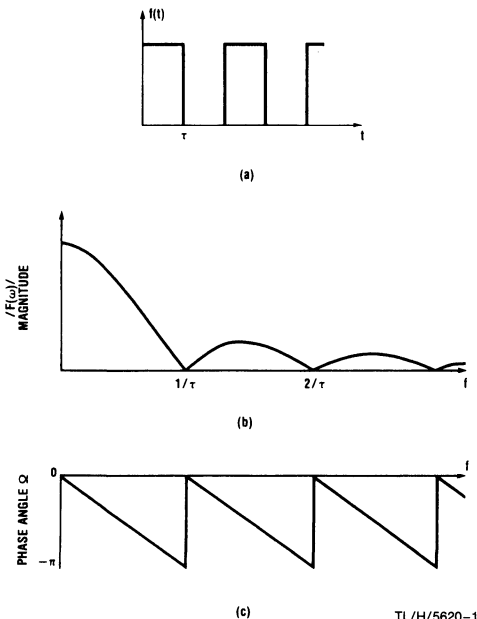
$$H(\omega) = A \left[\tau \frac{\sin \omega \tau}{\omega \tau} + j \frac{1}{\omega} (\cos \omega \tau - 1) \right] \quad (20)$$



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FIGURE 13. The Fourier transform of the rectangular pulse (a) is shown in (b).

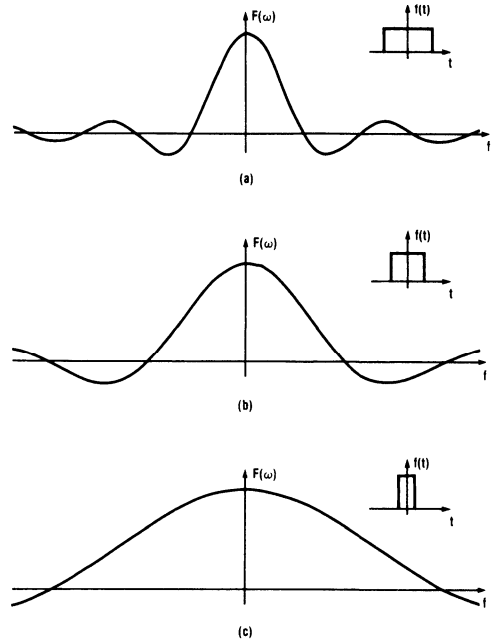
is shown in *Figure 14* and *Figure 15* illustrates the spectra of various sampler pulse-widths. The purpose of presenting this illustrative information is to give insight as to what effects cause the aliasing described in *Figure 10*. From *Figure 15* it is realized that the main lobe of the $\text{sin } X/X$ function varies inversely proportional with the sampler pulse-width. In other words a wide pulse-width, or in this case the aperture window, acts as a low pass filtering function and



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FIGURE 14. Sampling Pulse (a), its Magnitude (b) and Phase Response (c).

limits the amount of information resolvable by the sample data system. On the other hand a narrow sampler pulse-width or aperture window has a broader main lobe or bandwidth and thus when convolved with the analog input signal produces the least amount of distortion. Understandably then the effect of the sampler's spectral phase and main lobe width must be considered when developing a sampling system so that no unexpected aliasing occurs from its convolution with the input signal spectrum.



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FIGURE 15. Pulse width and how it effects the $\text{sin } X/X$ envelop spectrum (normalized amplitudes).

C. The Digital-to-Analog Converter and Smoothing Filter

After a signal has been digitally conditioned by the signal processing unit of *Figure 7*, a D/A converter is used to convert the sampled binary information back in to an analog signal. The conversion is called a zero order hold type where each output sample level is a function of its binary weight value and is held until the next sample arrives, see *Figure 16*. As a result of the D/A converter step function response it is apparent that a large amount of undesirable high frequency energy is present. To eliminate this the D/A converter is usually followed by a smoothing filter, having a cutoff frequency no greater than half the sampling frequency. As its name suggests the filter output produces a smoothed version of the D/A converter output which in fact is a convolved function. More simply said, the spectrum of the resulting signal is the product of a step function $\text{sin } X/X$ spectrum and the band-limited analog filter spectrum. Analogous to the input sampling problem, the smoothed output may have aliasing effects resulting from the phase and attenuation relations of the signal recovery system (defined as

the D/A converter and smoothing filter combination). As a final note, the attenuation due to the D/A converter $\sin X/X$ spectrum shape may in some cases be compensated for in the signal processing unit by pre-processing using a digital filter with an inverse response $X/\sin X$ prior to D/A conversion. This allows an overall flat magnitude signal response to be smoothed by the final filter.

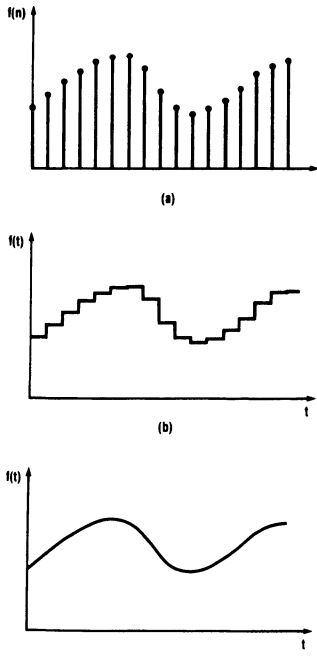


FIGURE 16. (a) Processed signal data points
(b) output of D/A converter
(c) output of smoothing filter.

V. A Final Note

This article began by presenting an intuitive development of the sampling theorem supported by a mathematical and illustrative proof. Following the theoretical development were a few of the unobvious and troublesome results that develop when trying to put the sampling theorem into practice. The purpose of presenting these thought provoking perils was to perhaps give the beginning designer some insight or guidelines for consideration when developing a sample data system's interface.

VI. Acknowledgements

The author wishes to thank James Moyer and Barry Siegel for their encouragement and the time they allocated for the writing of this article.

APPENDIX A

Basic Filter Concepts

A filter is a network used for separating signal waves on the basis of their frequency and is usually composed of

passive, reactive and active elements such as resistors, capacitors, inductors, and amplifiers, or combinations thereof. There are basically five types of filters used to pass or reject such signals and they are defined as follows:

1. A low-pass filter passes a band of frequencies called the *passband*, ranging from zero frequency or DC to a certain *cutoff frequency*, ω_c^* , and in addition has a maximum attenuation or ripple level of A_{MAX} within the passband. See Figure 1.

*Recall that the radian frequency $\omega = 2\pi f$.

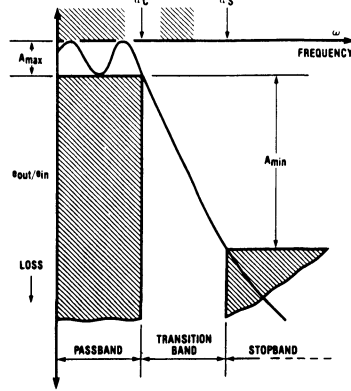


FIGURE 1. Common Low Pass Filter Response

Frequencies beyond the ω_c may have an attenuation greater than A_{MAX} but beyond a specific frequency ω_s defined as the *stopband frequency*, a minimum attenuation of A_{MIN} must prevail. The band of frequencies higher than ω_s and maintaining attenuation greater than or equal to A_{MIN} is called the *stopband*. The transition region or *transition band* is that band of frequencies between ω_c and ω_s .

2. A high-pass filter allows frequencies above the passband frequency, ω_c , to pass and rejects frequencies below this point. A_{MAX} must be maintained in the passband and frequencies equal to and below the stopband frequency, ω_s , must have a minimum attenuation of A_{MIN} . See Figure 2.

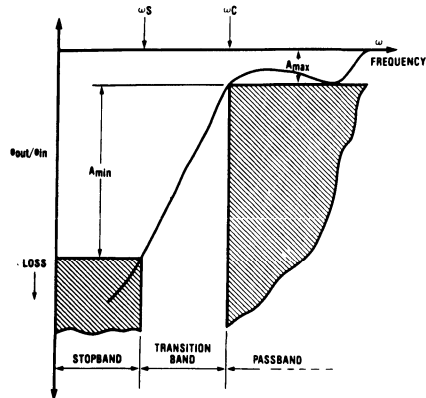
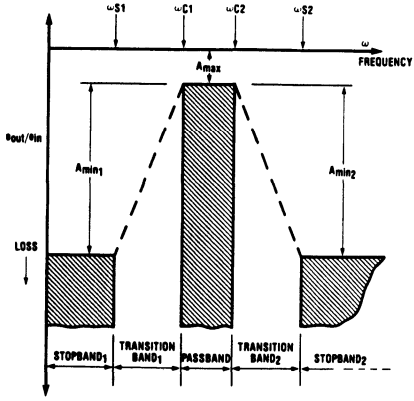


FIGURE 2. Common High Pass Filter Response

3. A bandpass filter performs the function of passing a specific band of frequencies while rejecting those frequencies above and below ω_{c2} and lower, ω_{c1} cutoff frequency limits. See *Figure 3*.



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Figure 3. Common Band-pass Filter Response
As in the previous two cases the passband is required to sustain an attenuation of A_{MAX} , and the stopband of frequencies above and below ω_{s2} and ω_{s1} respectively, must have a minimum attenuation of A_{MIN} .

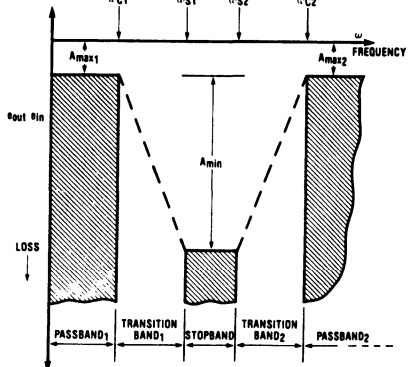
4. A band-reject filter or notch filter allows all but a specific band of frequencies to pass. As shown in *Figure 4*, those frequencies between ω_{s1} and ω_{s2} are filtered out and those frequencies above and below ω_{c2} and ω_{c1} respectively are passed. The attenuation requirements of the stopband A_{MIN} and passband A_{MAX} must still hold.

5. An all-pass or phase shift filter allows all frequencies to pass without any appreciable attenuation. It further introduces a predictable phase shift to all frequencies passed, though not restricting the entire range of frequencies to a specific phase shift (i.e., a phase shift may be imposed upon a selected band of frequencies and appear invisible to all others).

APPENDIX B

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Figure 4. Common Band-Reject Filter Response

CONVOLUTION: Digital Signal Processing

National Semiconductor
Application Note 237



Introduction

As digital signal processing continues to emerge as a major discipline in the field of electrical engineering, an even greater demand has evolved to understand the basic theoretical concepts involved in the development of varied and diverse signal processing systems. The most fundamental concepts employed are (not necessarily listed in the order of importance) the sampling theorem^[1], Fourier transforms [2] [3], convolution, covariance, etc.

The intent of this article will be to address the concept of convolution and to present it in an introductory manner hopefully easily understood by those entering the field of digital signal processing.

It may be appropriate to note that this article is Part II (Part I is titled "An Introduction to the Sampling Theorem") of a series of articles to be written that deal with the fundamental concepts of digital signal processing.

Let us proceed

Part II Convolution

Perhaps the easiest way to understand the concept of convolution would be an approach that initially clarifies a subject relating to the frequency spectrum of linear networks.

Determining the frequency spectrum or frequency transfer function of a linear network provides one with the knowledge of how a network will respond to or alter an input signal. Conventional methods used to determine this entail the use of spectrum analyzers which use either sweep generators or variable-frequency oscillators to impress upon a network all possible frequencies of equal amplitude and equal phase.

The response of a network to all frequencies can thus be determined. Any amplitude and phase variations at the output of a network are due to the network itself and as a result define the frequency transfer function.

Another means of obtaining this same information would be to apply an impulse function to the input of a network and then analyze the network impulse-response for its spectral-frequency content. Comparison of the network-frequency transfer function obtained by the two techniques would yield the same information.

This is found to be easily understood (without elaborate experimentation) if the implications of the impulse function are initially clarified.

If the pulse of *Figure 1a* is examined, using the Fourier integral, its frequency spectrum is found to be

$$F(\omega) = \int_{-\infty}^{\infty} f(t) \epsilon^{-j\omega t} dt \quad (1)$$

$$= \int_{-T/2}^{T/2} A \epsilon^{-j\omega t} dt \quad (2)$$

$$F(\omega) = AT \left[\frac{\sin\left(\frac{\omega T}{2}\right)}{\left(\frac{\omega T}{2}\right)} \right]$$

as shown in *Figure 1b*.

Decreasing the pulse width while increasing the pulse height to allow the area under the pulse to remain constant, *Figure 1c*, shows from eq(1) and eq(2) the bandwidth or spectral-frequency content of the pulse to have increased, *Figure 1d*.

Further altering the pulse to that of *Figure 1e* provides for an even broader bandwidth, *Figure 1f*. If the pulse is finally altered to the limit, i.e., the pulsewidth being infinitely narrow and its amplitude adjusted to still maintain an area of unity under the pulse, it is found in 1g and 1h the unit impulse produces a constant, or "flat" spectrum equal to 1 at all frequencies. Note that if $AT = 1$ (unit area), we get, by definition, the unit impulse function in time.

Since this time function contains equal frequency components at all frequencies, applying it or a good approximation of it to the input of a linear network would be the equivalent of simultaneously impressing upon the system an array of oscillators inclusive of all possible frequencies, all of equal amplitude and phase. The frequencies could thus be determined from this one input time function. Again, variations in amplitude and phase at the system output would be due to the system itself.

Empirically speaking the frequency spectrum or the network frequency transfer function can thus be determined by applying an impulse at the input and using, for example, a spectrum analyzer at the network output. At this point, it is important to emphasize that the above discussion holds true for only linear networks or systems since the superposition principle (The response to a sum of excitations is equal to the sum of the responses to the excitations acting separately), and its analytical techniques break down in non-linear networks.

Since an impulse response provides information of a network frequency spectrum or transfer function, it additionally provides a means of determining the network response to any other time function input. This will become evident in the following development.

If the input to a network, *Figure 2*, having a transfer function $H(\omega)$ is an impulse function $\delta(t)$ at $t=0$, its Fourier transform using eq(1) can be found to be $F(\omega) = 1$.

The output of the network $G(\omega)$ is therefore

$$G(\omega) = H(\omega) \bullet F(\omega)$$

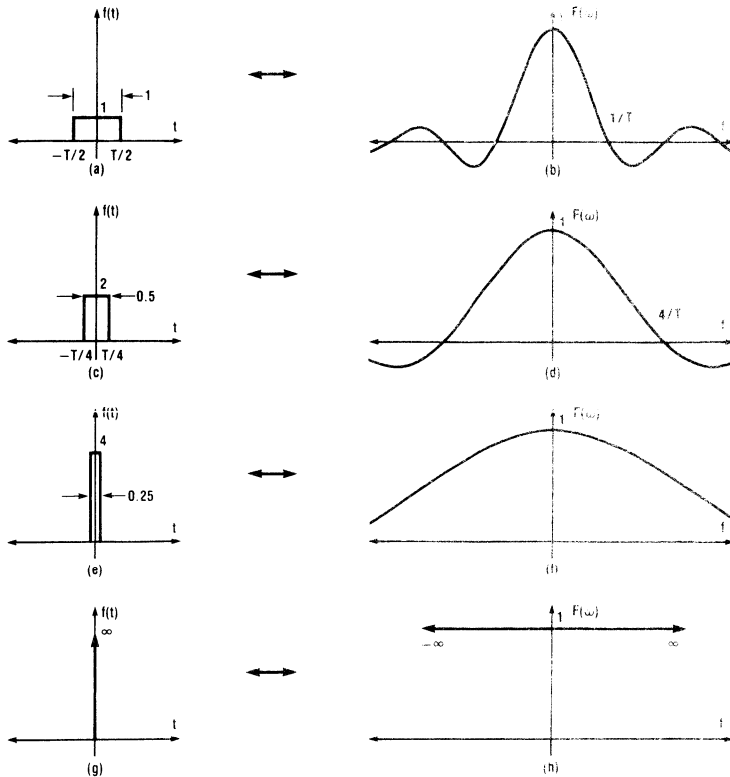
$$G(\omega) = H(\omega)$$

The inverse transform is

$$g(t) = h(t)$$

and $h(T)$ is defined as the impulse response of the network as a result of being excited by a unit impulse time function at $t=0$.

Extending this train of thought further, the response of a network to any input excitation can be determined using the same technique.



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FIGURE 1. Development of a unit impulse;
(a) (c) (e) (g) its time function
(b) (d) (f) (h) its frequency spectrum

Hence, finding the Fourier transform of the input excitation, $F(\omega)$, multiplying it by the transfer function transform $H(\omega)$ (or the transform of time domain network impulse response) and inverse transforming to find the output $g(t)$ as a function of time.

By definition the convolution integral¹

$$f(t) * h(t) = \int_0^t f(\tau) h(t - \tau) d\tau \quad (3)$$

(where * denotes the convolution operation, $h(t)$ denotes the impulse response function described above and both $f(t)$ and $h(t)$ are zero for $t < 0$. Note that the meaning of the variables t and τ will be clarified, later in the article) makes the same claim but in the realm of the time domain alone.

If this is true then the Fourier transform of the convolution integral eq(3) should have the following equivalence -

$$F \left[\int_0^t f(\tau) h(t - \tau) d\tau \right] = F(\omega) \bullet H(\omega) \quad (4)$$

As a proof using eq(1) let

$$F \left[f(t) * h(t) \right] = \int_0^\infty e^{-j\omega t} \left[\int_0^t f(\tau) h(t - \tau) d\tau \right] dt \quad (5)$$

Defined by the shifted step function

$$u(t - \tau) = 1 \text{ for } \tau < t \quad (6a)$$

and

$$u(t - \tau) = 0 \text{ for } \tau > t \quad (6b)$$

Footnote:

1. It is important to note that the convolution integral is commutative. This implies the reversability of the $f(t)$ and $h(t)$ terms in the definition.

$$g(t) = \int_{-\infty}^\infty f(\tau) h(t - \tau) d\tau = F^{-1} [F(\omega) \bullet H(\omega)]$$

$$\int_{-\infty}^\infty f(t - \tau) h(\tau) d\tau = F^{-1} [H(\omega) \bullet F(\omega)]$$

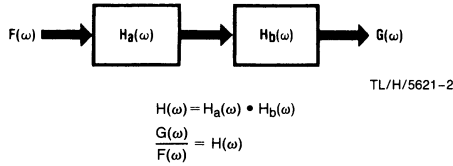


FIGURE 2. Block diagram of a network transfer function

the following identity can be made

$$\int_0^t f(\tau) h(t - \tau) d\tau = \int_0^\infty f(\tau) h(t - \tau) u(t - \tau) d\tau \quad (7)$$

Rewriting eq(5) as

$$F[f(t) * h(t)] = \int_0^\infty \epsilon^{-j\omega t} \int_0^\infty f(\tau) h(t - \tau) u(t - \tau) d\tau dt \quad (8)$$

and letting $x = t - \tau$ so that

$$\epsilon^{-j\omega t} = \epsilon^{-j\omega(x + \tau)} \quad (9)$$

eq(8) finally becomes

$$\begin{aligned}
 F[f(t) * h(t)] &= \int_0^\infty \int_0^\infty f(\tau) h(x) u(x) \epsilon^{-j\omega t} \epsilon^{-j\omega x} d\tau dx \\
 &= \int_0^\infty h(x) u(x) * \epsilon^{-j\omega x} dx \int_0^\infty f(\tau) \epsilon^{-j\omega \tau} d\tau
 \end{aligned}$$

$$F[f(t) * h(t)] = H(\omega) \cdot F(\omega) \quad (10)$$

which is the equivalent of eq(4).

In essence the above proof describes one of the most important and powerful tools used in signal processing . . . the convolution theorem. In words,

Convolution Theorem:

The convolution theorem allows one to mathematically convolve in the time domain by simply multiplying in the frequency domain. That is, if $f(t)$ has the Fourier transform $F(\omega)$ and $x(t)$ has the Fourier transform $X(\omega)$, then the convolution $f(t) * x(t)$ has the Fourier transform $F(\omega) \cdot X(\omega)$.

For the time convolution

$$f(t) * x(t) \longleftrightarrow F(\omega) \cdot X(\omega) \quad (11)$$

and the dual frequency convolution is

$$f(t) \cdot x(t) \longleftrightarrow F(\omega) * X(\omega) \quad (12)$$

Convolutions are fundamental to time series sampled data analysis. First of all, as described earlier all linear networks can be completely characterized by their impulse response functions and furthermore the response to any input is given by its (the input function) convolution with the network impulse response function. Digit filters being linear systems accomplish the filtering task using convolutions. A network or filter transfer function for example can be represented by its impulse response in the form of a Fourier series. A filtered input excitation response can then be found by convolving the input time function with the network Fourier series or impulse response. With the aid of a high speed computer the same result could be obtained by storing the FFT (Fast Fourier Transform) of the network impulse response into memory, performing an FFT on the sampled continuous in-

put excitation function, multiplying the two transforms and finally computing the inverse FFT of the product.

Moving averages and smoothing operations can further be characterized as lowpass filtering functions and can additionally be implemented using convolution. The above are just a few of the many operations convolution performs and the remainder of this discussion will focus on how convolution is realized.

To start with, an illustrative analysis will be performed assuming continuous functions followed by one performed in discrete form similar to that realized in computer aided sampled-data systems techniques.

As an example, if it were desired to determine the response of a network to the excitation pulse $f(t)$ shown in *Figure 3a*, knowing the network impulse $h_\delta(t)$, *Figure 3b*, the impulse response of an RC network, would allow one to determine the output $g(t)$ using the convolution integral, eq(3).

The convolution of $f(t)$ and $h_\delta(t)$

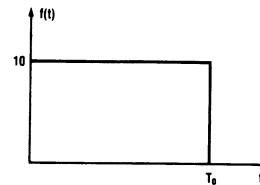
$$\begin{aligned}
 f(t) &= 10[u(t) - (u(t - T_0))] \\
 h_\delta(t) &= \epsilon^{-at}
 \end{aligned} \quad (13)$$

could be obtained by first substituting the dummy variable $t - \tau$ for t in $h_\delta(t)$ so that

$$h_\delta(t - \tau) = \epsilon^{-a(t - \tau)} \quad (15)$$

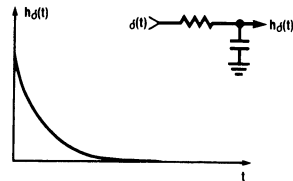
By definition $g(t) = f(t) * h_\delta(t)$ thus becomes

$$\int_0^t f(\tau) h_\delta(t - \tau) d\tau = \int_0^t 10[u(t) - u(t - T_0)] \epsilon^{-a(t - \tau)} d\tau \quad (16)$$



$$f(t) = 10[u(t) - u(t - T_0)] \quad (a)$$

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$$h_\delta(t) = \epsilon^{-at} \quad (b)$$

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FIGURE 3. (a) rectangular pulse excitation (b) impulse response of a single RC network

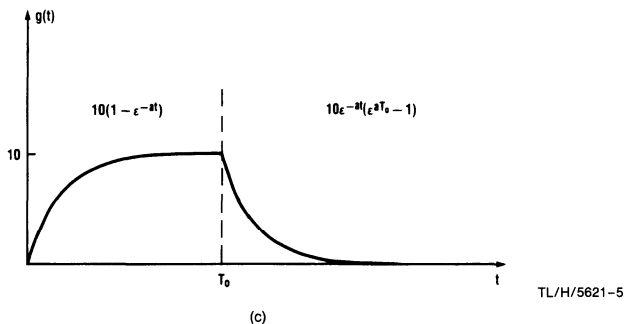


FIGURE 3. (c) output or convolution of the network (b) excited by (a)

Since the piecewise nature of the excitation makes it convenient to calculate the response in corresponding pieces the output is found to be

$$\begin{aligned}
 0 < t \leq T_0 \\
 g(t) &= f(t) h_\delta(t) = \int_0^t 10\epsilon^{-a(t-\tau)} d\tau \\
 &= 10(1 - \epsilon^{-at}) \tag{17}
 \end{aligned}$$

$$\begin{aligned}
 t \geq T_0 \\
 g(t) &= f(t) * h_\delta(t) = \int_0^{T_0} 10\epsilon^{-a(t-\tau)} d\tau \\
 &= 10\epsilon^{-at} (\epsilon^{aT_0} - 1) \tag{18}
 \end{aligned}$$

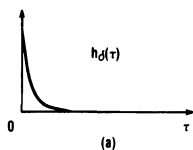
The output response $g(t)$ is plotted in *Figure 3c* and is clearly what might be expected from a simple RC network excited by a rectangular pulse.

Though simplistic in its nature, the analysis of the above example quickly becomes unrealistically cumbersome when complex excitation and impulse response functions are used. Turning to a numerical evaluation of the convolution integral may perhaps be the most desirable method of realization. Prior to a numerical development however, an intuitive graphical illustration of convolution will be presented which should make discrete numeric convolution easily understood.

The convolution integral —

$$\int_0^t f(\tau) h_\delta(t - \tau) d\tau$$

IMPULSE RESPONSE



EXCITATION

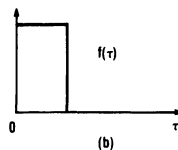


FIGURE 4. a) $h_\delta(\tau)$: network impulse response
b) $f(\tau)$: excitation function

defines the graphical procedure. Using the same example depicted in *Figure 3* the excitation and impulse response functions replaced with the dummy variable is defined as past data or historical information to be used in a convolution process. Thus

$$f(\tau) = 10[u(\tau) - u(\tau - T_0)] \tag{19}$$

and

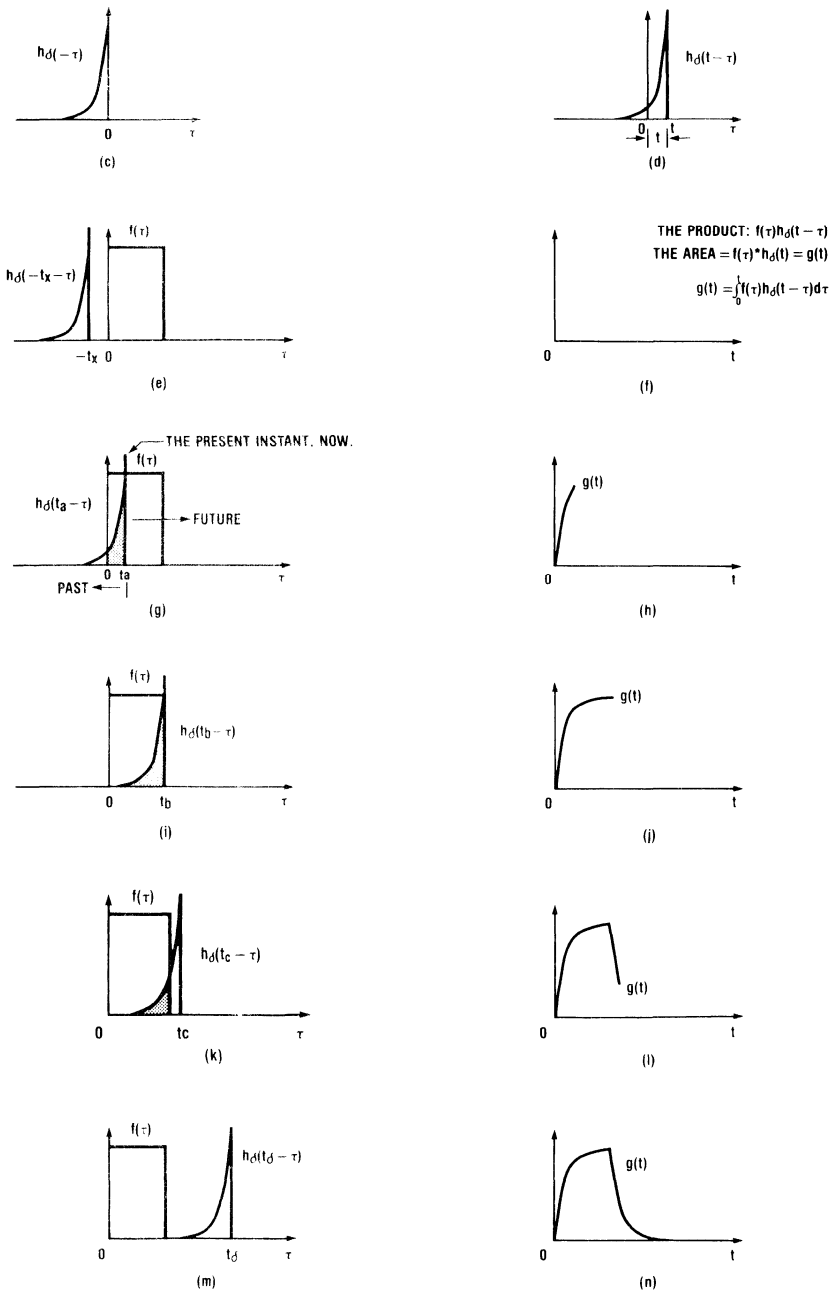
$$h_\delta(\tau) = \epsilon^{-a\tau} \tag{20}$$

are shown in *Figure 4a* and *b*. *Figure 4c*, $h_\delta(-\tau)$, represents the impulse response folded over [mirror image of $h_\delta(\tau)$] about the ordinate and *Figure 4d*, $h_\delta(t - \tau)$, is simply the function $h_\delta(-\tau)$ time shifted by the quantity t .

Evaluation of the convolution integral is performed by multiplying $f(\tau)$ by each incremental shift in $h_\delta(t - \tau)$. It is understood in *Figure 4e* that a negative value of $-t$ produces no output. For $t > 0$ however as the present time t varies, the impulse response $h_\delta(t - \tau)$ scans the excitation function $f(\tau)$, always producing a weighted sum of past inputs and weighing most heavily those values of $f(\tau)$ closest to the present. As seen in *Figures 4e* through *4n*, the response or output of the network at anytime t is the integral of the functions or calculated shaded area under the curves. In terms of the superposition principle the filter response $g(t)$ may be interpreted as being the weighted superposition of past input $f(\tau)$ values weighted or multiplied by $h_\delta(t - \tau)$.

An extension of the continuous convolution to its numerical discrete form is made and shown in *Figure 5*. Again the excitation and impulse response of *Figure 3* are used and are further represented as two finite duration sequences $f(n)$

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**FIGURE 4. cont'd c) $h_\delta(-\tau)$: $h_\delta(\tau)$ folded about the ordinate
d) $h_\delta(t-\tau)$: $h_\delta(\tau)$ folded and shifted
e) through n) the output response $g(t)$ of the network whose
impulse response $h_\delta(\tau)$ is excited by a function $f(\tau)$.
Or the convolution, $f(\tau) * h_\delta(t)$, of $f(t)$ with $h_\delta(t)$.**

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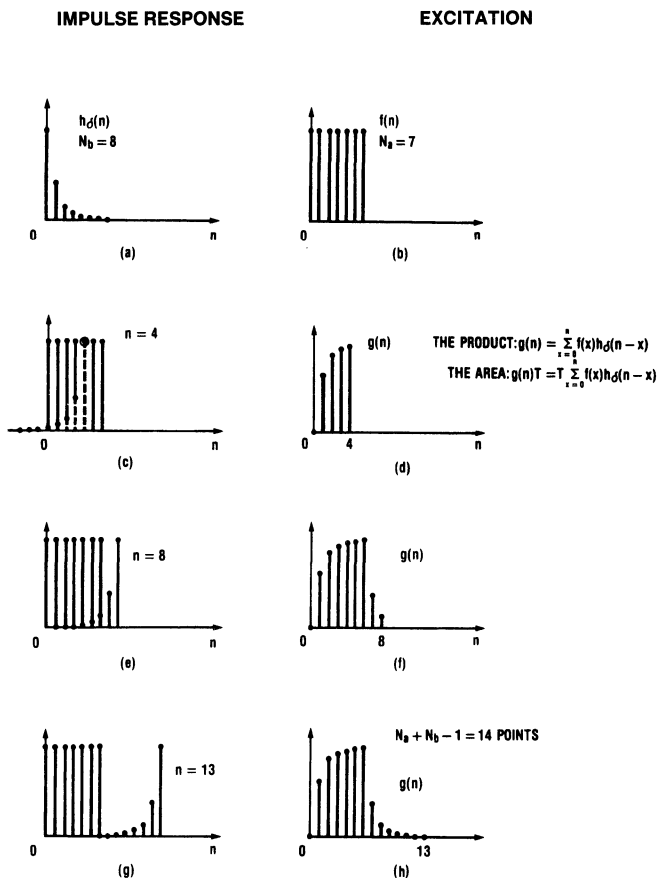


FIGURE 5. Illustrative description of discrete convolution

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and $h_{\delta}(n)$ respectively, *Figures 5a and b*.

It is observed additionally that the duration of $f(n)$ is $N_a = 7$ samples [$f(n)$ is nonzero for the interval $0 \leq n \leq N_a - 1$ and the duration of $h_{\delta}(n)$ is $N_b = 8$ samples [$h_{\delta}(n)$ is nonzero for the interval $0 \leq n \leq N_b - 1$]. The sequence $g(n)$, a discrete convolution, can thus be defined as

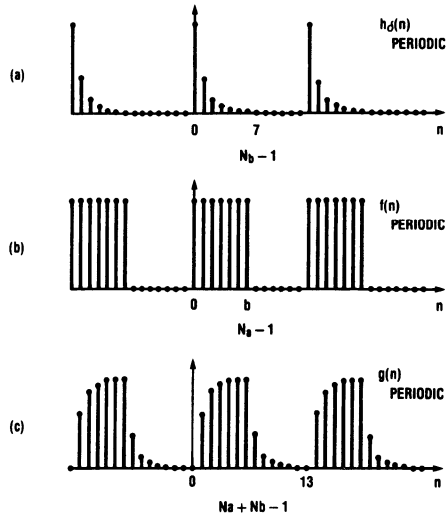
$$g(n) = \sum_{x=0}^n f(x) h_{\delta}(n-x) \quad (21)$$

having a finite duration sequence of $N_a + N_b - 1$ samples, *Figure 5h*. The convolution using numerical integration (area under the curve) can be defined as

$$g(n)T = T \sum_{x=0}^n f(x) h_{\delta}(n-x) \quad (22)$$

where T is the sampling interval used to obtain the sampled data sequences.

If $f(n)$ and $h_{\delta}(n)$ were next considered to be periodic sequences and a convolution was desired using either shifting techniques or performing an FFT on the excitation and impulse response sequences and finally inverse FFT transforming to achieve the output response, some care must be taken when preparing the convolving sequences. From *Figure 5h* it is observed that the convolution is completed in a $N_a + N_b - 1$ point sequence. To acquire the nonoverlapping or nondistorted periodic sequence of *Figure 6c* the convolution thus requires $f(n)$ and $h_{\delta}(n)$ to be $N_a + N_b - 1$ point sequences. This is achieved by appending the appropriate number of zero valued samples, also known as zero filling, to $f(n)$ and $h_{\delta}(n)$ to make them both $N_a + N_b - 1$ point sequences. The undistorted and correct convolution can now be performed using the zero filled sequences *Figure 6a and 6b* to achieve *6c*.



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FIGURE 6. Linear periodic discrete convolution of $f(n)$ and $h_\delta(n)$, $f(n) * h_\delta(n)$.

A Final Note

This article attempted to simplify the not-so-obvious concept of convolution by first developing the reader's knowledge and feel for the implications of the impulse function and its effect upon linear networks. This was followed by a short discussion of network transfer functions and their relative spectrum. Having set the stage, the convolution integral and theorem were introduced and supported with an analytical and illustrative example. This example showed how the response of a simple RC network excited by a rectangular pulse could be determined using the convolution integral.

Finally, two examples of discrete convolution were presented. The first example dealt with finite duration sequences and the second dealt with periodic sequences. Additionally, precautions in the selection of n -point sequences was discussed in the second example to alleviate distorting or spectrally overlapping the excitation and impulse response functions during the convolution process.

Appendix A

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Acknowledgements

The author wishes to thank James Moyer and Barry Siegel for their guidance and constructive criticisms.

Wide-Range Current-to-Frequency Converters

National Semiconductor
Application Note 240
Robert A. Pease



Does an analog-to-digital converter cost you a lot if you need many bits of accuracy and dynamic range? Absolute accuracy better than 0.1% is likely to be expensive. But a capability for wide dynamic range can be quite inexpensive. Voltage-to-frequency (V-to-F) converters are becoming popular as a low-cost form of A-to-D conversion because they can handle a wide dynamic range of signals with good accuracy.

Most voltage-to-frequency (V-to-F) converters actually operate with an input current which is proportional to the voltage input:

$$I_{IN} = \frac{V_{IN}}{R_{IN}}$$

(Figure 1). This current is integrated by an op amp, and a charge dispenser acts as the feedback path, to balance out the average input current. When an amount of charge $Q = I \cdot T$ (or $Q = C \cdot V$) per cycle is dispensed by the circuit, then the frequency will be:

$$f = \left(\frac{V_{IN} - V_{OS}}{R_{IN}} + I_b \right) \times \frac{1}{Q}$$

When V_{IN} is large:

$$f \approx \frac{V_{IN}}{R_{IN}} \times \frac{1}{Q}$$

When V_{IN} covers a wide dynamic range, the V_{OS} and I_b of the op amp must be considered, as they greatly affect the usable accuracy when the input signal is very small. For example, when the full-scale input is 10V, a signal which is 100 dB below full-scale will be only 100 μ V. If the op amp has an offset drift of $\pm 100 \mu$ V, (whether caused by time or temperature), that would cause a $\pm 100\%$ error at this signal level. However, a current-to-frequency converter can easily cover a 120 dB range because the voltage offset problem is not significant when the input signal is actually a current source. Let's study the architecture and design of a current-to-frequency converter, to see where we can take advantage of this.

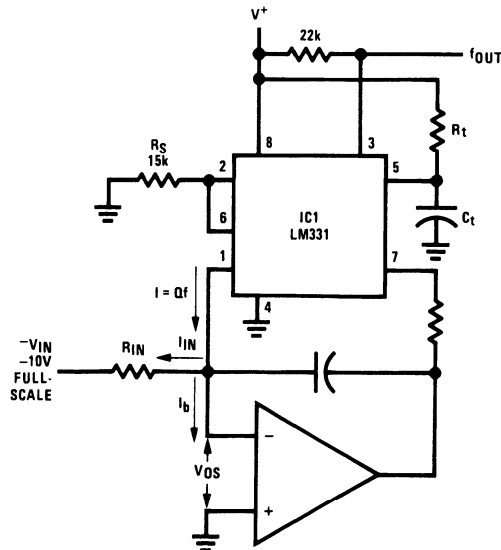


FIGURE 1. Typical Voltage-to-Frequency Converter

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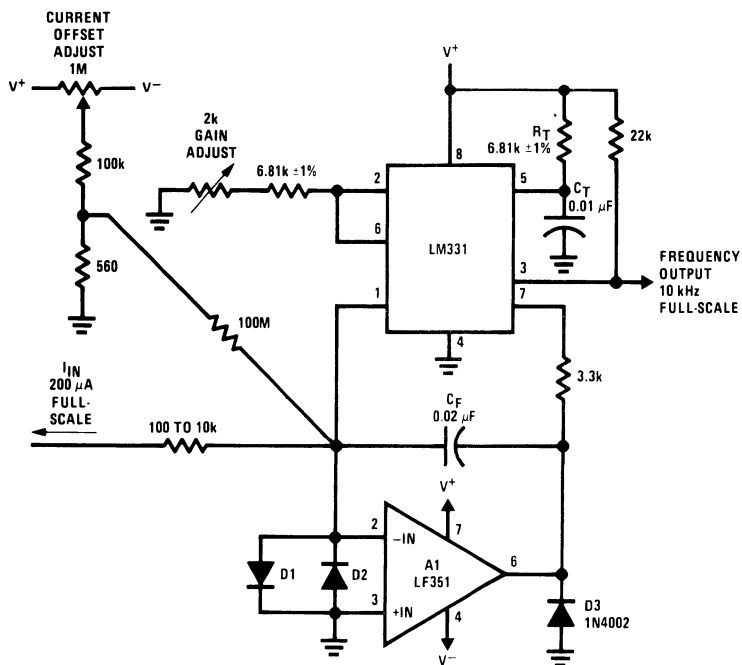
When the input signal is a current, the use of a low-voltage-drift op amp becomes of no advantage, and low bias current is the prime specification. A low-cost BI-FET™ op amp such as the LF351A has $I_b < 100$ pA, and temperature coefficient of I_b less than 10 pA/°C, at room temperature. In a typical circuit such as Figure 2, the leakage of the charge dispenser is important, too. The LM331 is only specified at 10 nA max at room temperature, because that is the smallest current which can be measured economically on high-speed test equipment. The leakage of the LM331's current-source output at pin 1 is usually 2 pA to 4 pA, and is always less than the 100 pA mentioned above, at 25°C .

The feedback capacitor C_F should be of a low-leakage type, such as polypropylene or polystyrene. (At any temperature above 35°C , mylar's leakage may be excessive.) Also, low-leakage diodes are recommended to protect the circuit's

input from any possible fault conditions at the input. (A 1N914 may leak 100 pA even with only 1 millivolt across it, and is unsuitable.)

After trimming this circuit for a low offset when I_{IN} is 1 nA, the circuit will operate with an input range of 120 dB, from 200 μA to 100 pA, and an accuracy or linearity error well below (0.02% of the signal plus 0.0001% of full-scale).

The zero-offset drift will be below 5 or 10 pA/°C, so when the input is 100 dB down from full-scale, the zero drift will be less than 2% of signal, for a $\pm 5^\circ\text{C}$ temperature range. Another way of indicating this performance is to realize that when the input is $1/1000$ of full-scale, zero drift will be less than 1% of that small signal, for a 0°C to 70°C temperature range.



D1, D2 = 1N457, 1N484, or similar low-leakage planar diode

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FIGURE 2. Practical Wide-Range Current-to-Frequency Converter

What if this isn't good enough? You *could* get a better op amp. For example, an LH0022C has 10 pA max I_b . But it is silly to pay for such a good op amp, with low V offset errors, when only a low input current specification is needed. The circuit of Figure 3a shows the simple scheme of using FET followers ahead of a conventional op amp. An LF351 type is suitable because it is a cheap, quick amplifier, well suited for this work. The 2N5909s have a maximum I_b of 1.0 pA, and at room temperature it will drift only 0.1 pA/°C. Typical drift is 0.02 pA/°C.

The voltage offset adjust pot is used to ring the summing point within a millivolt of ground. With an input signal big enough to cause $f_{OUT} = 1$ second per cycle, trim the V offset adjust pot so that closing the *test* switch makes no

effect on the output frequency (or, output period). Then adjust the input current offset pot, to get $f_{OUT} = 1/1000$ of full-scale when I_{IN} is 1/1000 of full-scale. When I_{IN} covers the 140 dB range, from 200 μ A to 20 pA, the output will be stable, with very good zero offset stability, for a limited temperature range around room temperature. Note these precautions and special procedures:

1. Run the LM331 on 5V to 6V to keep leakage down and to cut the dissipation and temperature rise, too.
2. Run the FETs with a 6V drain supply.
3. Guard all summing point wiring away from all other voltages.

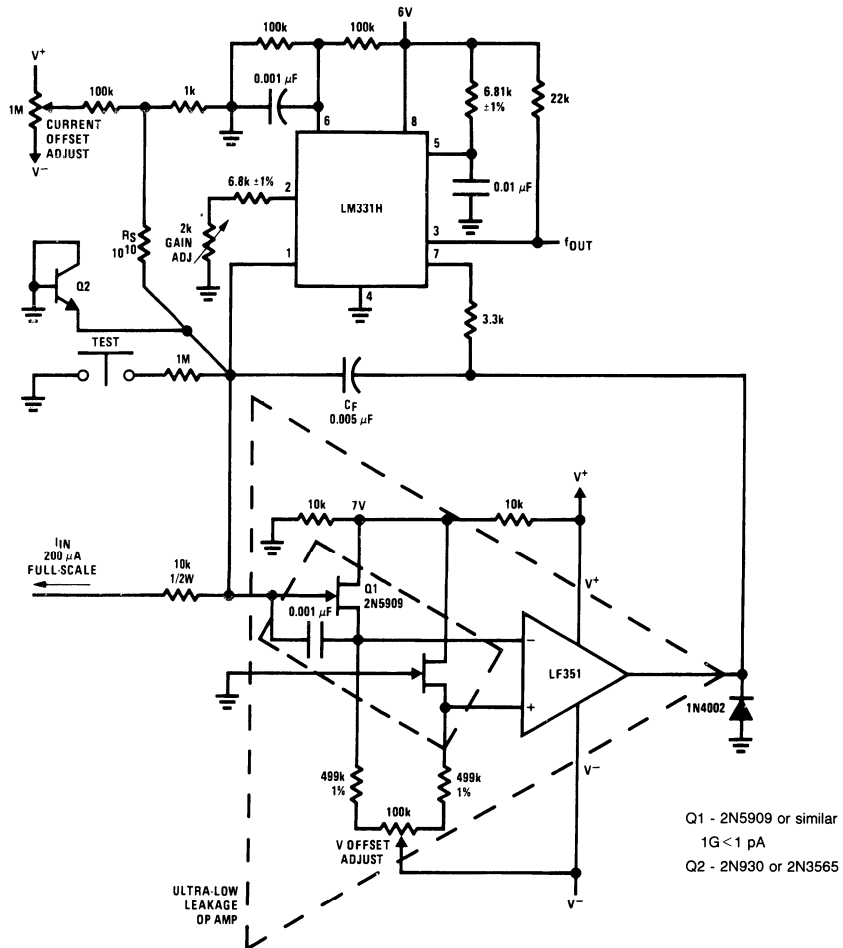


FIGURE 3a. Very-Wide-Range Current-to-Frequency Converter

An alternate approach, shown in *Figure 3b*, uses an LM11C as the input pre-amplifier. The LM11C has much better voltage drift than any of the other amplifiers shown here (normally less than $2 \mu\text{V}/^\circ\text{C}$) and excellent current drift, less than $1 \text{ pA}/^\circ\text{C}$ by itself, and typically $0.2 \text{ pA}/^\circ\text{C}$ when trimmed with the 2N3904 bias current compensation circuit as shown. Of course, the LM331's leakage of $1 \text{ pA}/^\circ\text{C}$ will still double every 10°C , so that having an amplifier with excellent I_b characteristics does not solve the whole problem, when trying to get good accuracy with a 100 pA signal. For that job, even the leakage of the LM331 must be guarded out!

What if even lower ranges of input current must be accepted? While it might be possible to use a current-to-voltage converter ahead of a V-to-F converter, offset voltage drifts would hurt dynamic range badly. Response and zero-drift of such an I-V will be disappointing. Also, it is not feasible to starve the LM331 to an arbitrary extent.

For example, while its I_{OUT} (full-scale) of $280 \mu\text{A}$ DC can be cut to $10 \mu\text{A}$ or $28 \mu\text{A}$, it cannot be cut to $1 \mu\text{A}$ or $2.8 \mu\text{A}$ with good accuracy at 10 kHz , because the internal switches in the integrated circuit will not operate with best speed and precision at such low currents.

Instead, the output current from pin 1 of the LM331 can be fed through a current attenuator circuit, as shown in *Figure 4*. The LM334 (temperature-to-current converter IC) causes -120 mV bias to appear at the base of Q2. When a current flows out of pin 1 of the LM331, $1/100$ of the current will flow out of Q1's collector, and the rest will go out of Q2's collector. As the LM334's current is linearly proportional to Kelvin temperature, the -120 mV at Q2's base will change linearly with temperature so that the Q1/Q2 current divider stays at 1:100, invariant of temperature, according to the equation:

$$i_1/i_2 = e^{\frac{q(V_{b1} - V_{b2})}{kT}}$$

This current attenuator will work stably and accurately, even at high speeds, such as for $4 \mu\text{s}$ current pulses. Thus, the output of Q1 is a charge pump which puts out only 10 picocoulombs per pulse, with surprisingly good accuracy. Note also that the LM331's leakage is substantially attenuated also, by a factor of 100 or more, so that source of error

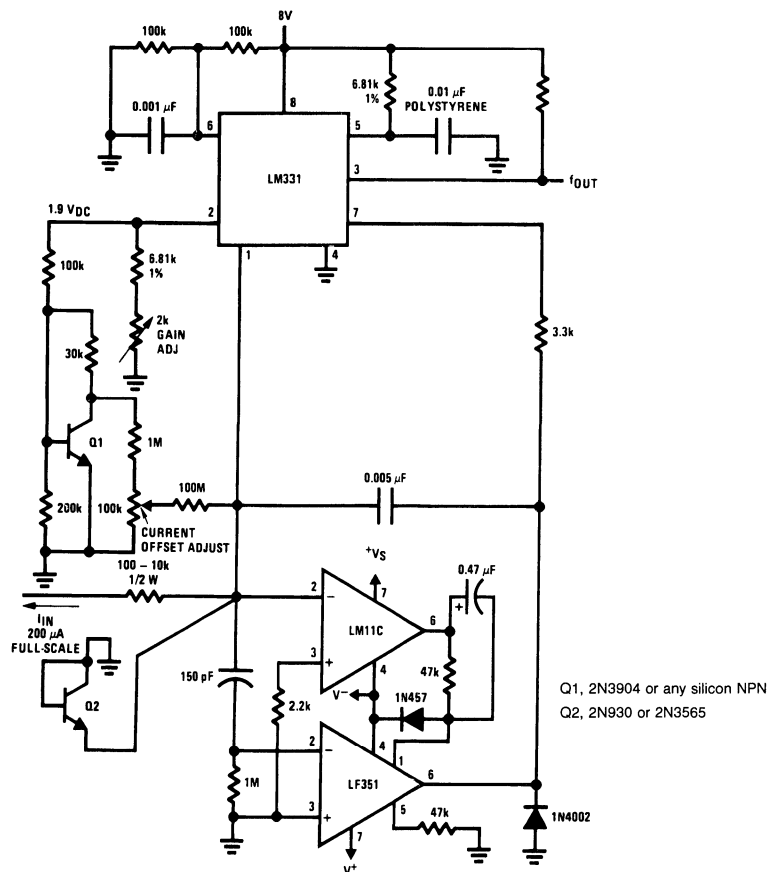


FIGURE 3b. Very-Wide-Range I-to-F Converter with Low Voltage Drift

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virtually disappears. When Q1 is off, it is really *OFF*, and its leakage is typically 0.01 pA if the summing point is within a millivolt or two of ground.

To do justice to this low leakage of the VFC, the op amp should be made with MOSFETs for Q3 and Q4, such as the Intersil 3N165 or 3N190 dual MOSFET (with no gate-protection diodes). When MOSFETs have relatively poor offset voltage, offset voltage drift, and voltage noise, this circuit does not care much about these characteristics, but instead takes advantage of the MOSFET's superior current leakage and current drift.

Now, with an input current of 1 μA , the full-scale output frequency will be 100 kHz. At a 1 nA input, the output frequency will be 100 Hz. And, when the input current is 1 pA, the output frequency will drop to 1 cycle per 10 seconds or 100 mHz. When the input current drops to zero, frequencies as small as 500 μHz have been observed, at 25°C and also as warm as 35°C. Here is a wide-range data converter whose zero drift is *well* below 1 ppm per 10°C! (Rather more like 0.001 ppm per°C.) The usable dynamic range is better than 140 dB, with excellent accuracy at inputs between 100% and 1% and 0.01% and 0.0001% of full-scale.

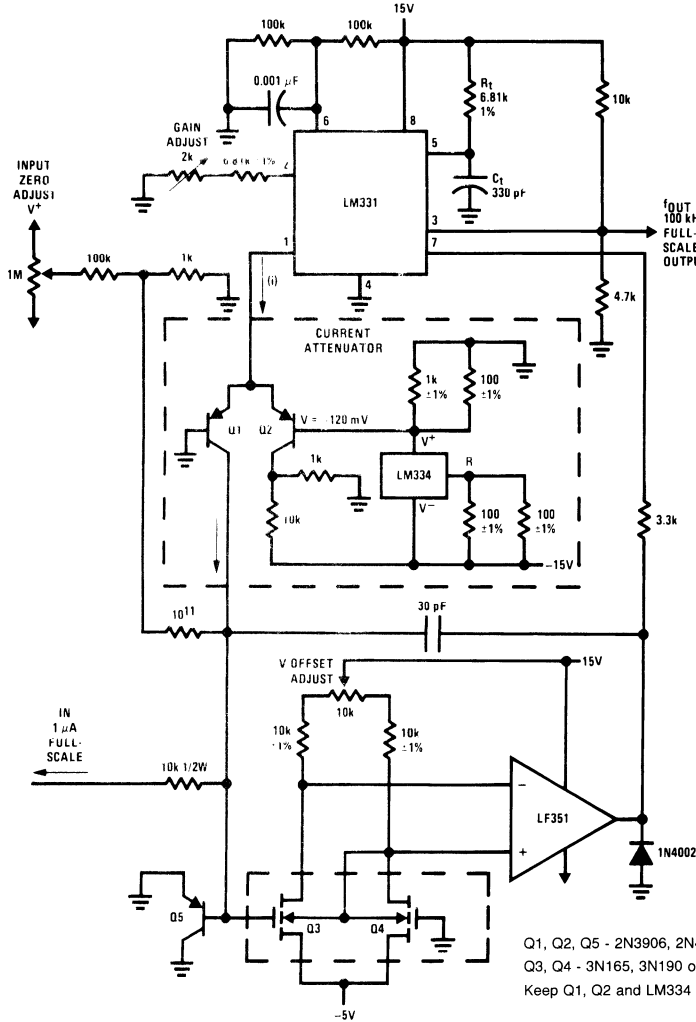


FIGURE 4. Picoampere-to-Frequency Converters

If a positive signal is of interest, the LM331 can be applied with a current reflector as in Figure 5. This current reflector has high output impedance, and low leakage. Its output can go directly to the summing point, or via a current attenuator made with NPN transistors, similar to the PNP circuit of Figure 4. This circuit has been observed to cover a wide (130 dB) range, with 0.1% of signal accuracy.

What is the significance of this wide-range current-to-frequency converter? In many industrial systems the question of using an inexpensive 8-bit converter instead of an expensive 12-bit data converter is a battle which is decided every day. But if the signal source is actually a current source, then you can use a V-to-F converter to make a cheap 14-bit converter or an inexpensive converter with 18 bits of dynamic range. The choice is yours.

Why use an I-to-F converter?

- It is a natural form of A-to-D conversion.
- It naturally facilitates integration, as well.
- There are many signals in the world, such as photospectrometer currents, which like to be digitized and integrated as a standard part of the analysis of the data.

- Similarly: photocurrents, dosimeters, ionization currents, are examples of currents which beg to be integrated in a current-to-frequency meter.
- Other signal sources which provide output currents are:
 - Phototransistors
 - Photo diodes
 - Photoresistors (with a fixed voltage bias)
 - Photomultiplier tubes
 - Some temperature sensors
 - Some IC signal conditioners

Why have a fast frequency out?

- A 100 kHz output full-scale frequency instead of 10 kHz means that you have 10 times the resolution of the signal. For example, when I_{IN} is 0.01% of full-scale, the f will be 10 Hz. If you integrate or count that frequency for just 10 seconds, you can resolve the signal to within 1% — a factor of 10 better than if the full-scale frequency were slower.

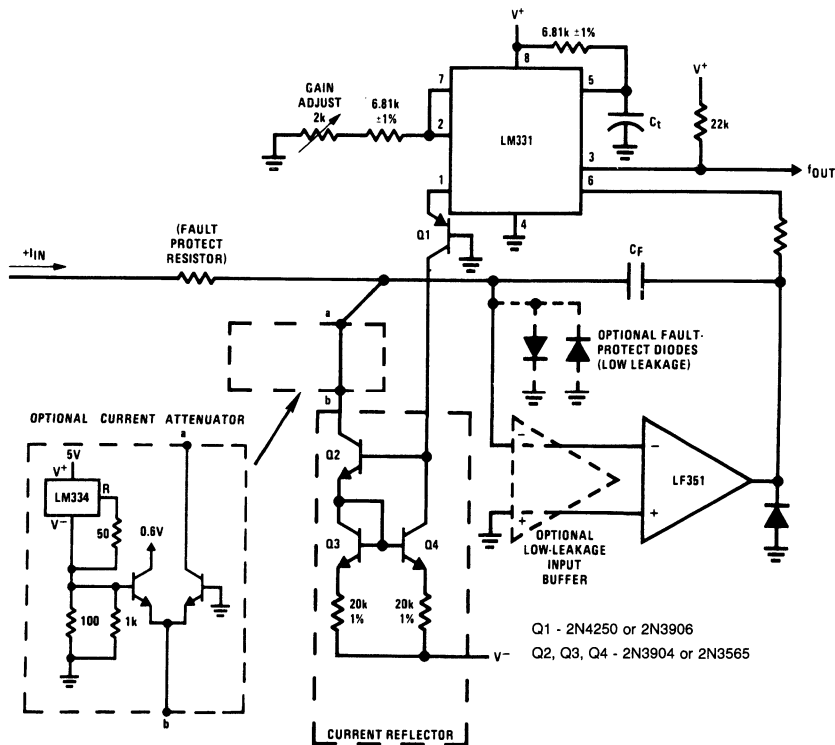


FIGURE 5. Current-to-Frequency Converter For Positive Signals

TL/H/5622-6

Working with High Impedance Op Amps

National Semiconductor
Application Note 241



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Abstract. *New developments have dramatically reduced the error currents of IC op amps, especially at high temperatures. The basic techniques used to obtain this performance are briefly described. Some of the problems associated with working at the high impedance levels that take advantage of these low error currents are discussed along with their solutions. The areas involved are printed-circuit board leakage, cable leakage and noise generation, semiconductor-switch leakages, large-value resistors and capacitor limitations.*

Introduction

A new, low cost op amp reduces dc error terms to where the amplifier may no longer be the limiting factor in many practical circuits. FET bias currents are equalled at room temperature; but unlike FETs, the bias current is relatively stable even over a -55°C to 125°C temperature range. Offset voltage and drift are low because bipolar inputs and on-wafer trimming are used. The $100\ \mu\text{V}$ offset voltage and $25\ \text{pA}$ bias current are expected to advance the state of the art for high impedance sensors and signal conditioners.

bias currents

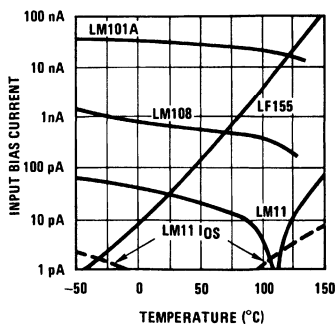
There has been a continual effort to reduce the bias current of IC op amps ever since the $\mu\text{A}709$ was introduced in 1965. The LM101A, announced in 1968, dropped this current by an order of magnitude through improved processing that gave better transistor current gain at low operating cur-

rents. In 1969, super-gain transistors (see appendix) were applied in the LM108 to beat FET performance when temperatures above 85°C were involved.

In 1974 FETs were integrated with bipolar devices to give the first FET op amp produced in volume, the LF155. These devices were faster than general purpose bipolar op amps and had lower bias current below 70°C . But FETs exhibit higher offset voltage and drift than bipolars. Long-term stability is also about an order of magnitude worse. Typically, this drift is $100\ \mu\text{V}/\text{year}$, but a small percentage could be as bad as $1\ \text{mV}$. Laser trimming and other process improvements have lowered initial offset but have not eliminated the drift problem.

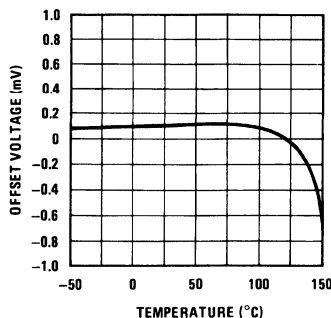
The new IC is an extension of super-gain bipolar techniques. As can be seen from *Figure 1*, it provides low bias currents over a -55°C to 125°C temperature range. The offset current is so low as to be lost in the noise. This level of performance has previously been unavailable for either low-cost industrial designs or high reliability military/space applications.

This low bias current has not been obtained at the expense of offset voltage or drift. Typical offset voltage is under a millivolt and provision is made for on-wafer trimming to get it below $100\ \mu\text{V}$. The low drift exhibited in *Figure 2* indicates that the circuit is inherently balanced for exceptionally low drift, typically $1\ \mu\text{V}/^{\circ}\text{C}$ below 100°C .



TL/H/7478-1

Figure 1. Comparison of typical bias currents for various types of IC op amps. New bipolar device not only has lower bias current over practical temperature ranges but also lower drift. Offset current is unusually low with the new design.



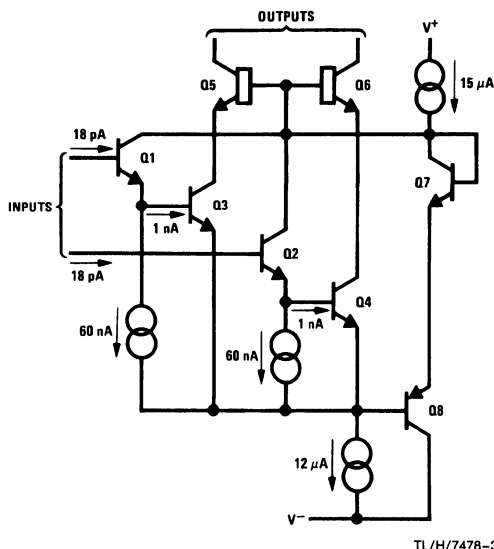
TL/H/7478-2

Figure 2. Bipolar transistors have inherently low offset voltage and drift. The low drift of the LM11 over a wide temperature range shows that there are no design problems degrading performance.

the new op amp

The LM11 is, in essence, a refinement of the LM108. A modified Darlington input stage has been added to reduce bias currents. With a standard Darlington, one transistor is biased with the base current of the other. This degrades dc amplifier performance because base current is noisy, subject to wide variation and generally unpredictable.

Supplying a bleed current greater than the base current, as shown in *Figure 3*, removes this objection. The 60 nA provided is considerably in excess of the 1 nA base current. The bleed current is made to vary as absolute temperature to maintain constant impedance at the emitters of Q1 and Q2. This stabilizes frequency response and also reduces the thermal variation of bias current. Parasitic capacitances of the current generator have been bootstrapped so that the 0.3 V/ μ s slew rate of the basic amplifier is unaffected.



TL/H/7478-3

Figure 3. Modifying Darlington with bleed current reduces offset voltage, drift and noise. Unique circuitry provides well-controlled current with minimal stray capacitance so that speed of the basic amplifier is unaffected.

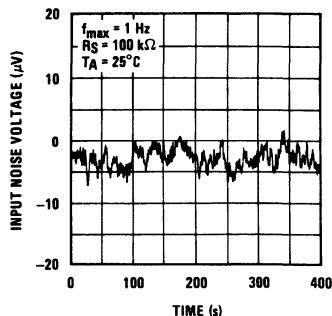
Results to date suggest that the base currents of this modified Darlington input are better matched than the simple differential amplifier. In fact, offset current is so low as to be unmeasurable on production test systems. Therefore, guaranteed limits are determined by the test equipment rather than the IC.

noise

Operating transistors at very low currents does increase noise. Thus, the LM11 is about a factor of four noisier than the LM108. But the low frequency noise, plotted in *Figure 4*, is still slightly less than that of FET amplifiers. Long-term measurements indicate that the offset voltage shift is under 10 μ V.

In contrast to the noise voltage, low frequency noise current is subject to greater unit-to-unit variation. Generally, it is below 1 pA, peak-to-peak, about the same magnitude as the offset current.

With the LM11, both voltage and current related dc errors have been reduced to the point where overall circuit performance could well be noise limited, particularly in limited temperature range applications.



TL/H/7478-4

Figure 4. Lower operating currents increase noise, but low frequency noise is still slightly lower than IC FET amplifiers. Long-term stability is much improved.

reliability

The reliability of the LM11 is not expected to be substantially different than the LM108, which has been used extensively in military and space applications. The only significant difference is the input stage. The low current nodes introduced here might possibly be a problem were they not bootstrapped, biased and guarded to be virtually unaffected by both bulk and surface leakages. This opinion is substantiated by preliminary life-test data.

This IC could, in fact, be expected to improve reliability when used to replace discrete or hybrid amplifiers that use selected components and have been trimmed and tweaked to give the required performance.

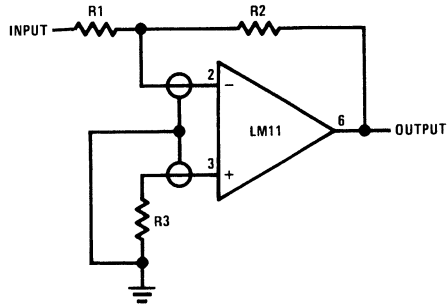
From an equipment standpoint, reliability analysis of insulating materials, surface contamination, cleaning procedures, surface coating and potting are at least as important as the IC and other components. These factors become more important as impedance levels are raised. But this should not discourage designers. If poor insulation and contamination cause a problem when impedance levels are raised by an order of magnitude, it is best found out and fixed.

Even so, it may not be advisable to take advantage of the full potential of the LM11 in all cases, especially when hostile environments are involved. For example, there should be no great difficulty in finding an LM11 with offset current less than 5 pA over a -55°C to 125°C temperature range. But anyone designing high-reliability equipment that is going to be in trouble if combined leakages are greater than 10 pA at 125°C had best know what he is about.

electrical guarding

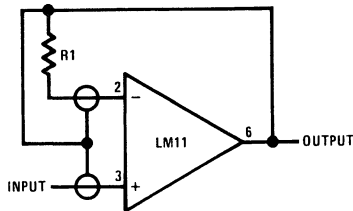
The effects of board leakage can be minimized using an old trick known as guarding. Here the input circuitry is surrounded by a conductive trace that is connected to a low impedance point at the same potential as the inputs. The electrical connection of the guard for the basic op amp configurations is shown in *Figure 5*. The guard absorbs the leakage from other points on the board, drastically reducing that reaching the input circuitry.

To be completely effective, there should be a guard ring on both sides of the printed-circuit board. It is still recommended for single-sided boards, but what happens on the unguarded side is difficult to analyze unless Teflon inserts are used on the input leads. Further, although surface leakage can be virtually eliminated, the reduction in bulk leakage is much less. The reduction in bulk leakage for double-sided guarding is about an order of magnitude, but this depends on board thickness and the width of the guard ring. If there are bulk leakage problems, Teflon inserts on the through holes and Teflon or kel-F standoffs for terminations can be used. These two materials have excellent surface properties without surface treatment even in high-humidity environments.



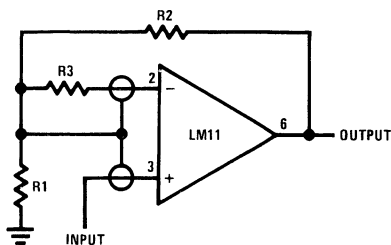
TL/H/7478-5

a. inverting amplifier



TL/H/7478-6

b. follower

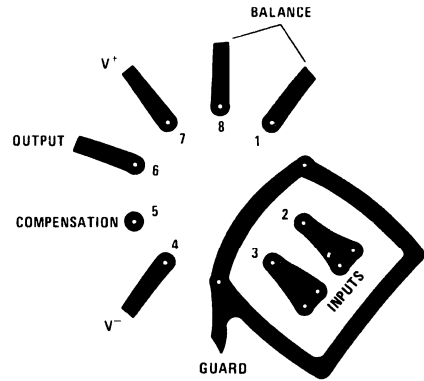


TL/H/7478-7

c. non-inverting amplifier

Figure 5. Input guarding for various op amp connections. The guard should be connected to a point at the same potential as the inputs with a low enough impedance to absorb board leakage without introducing excessive offset.

An example of a guarded layout for the metal-can package is shown in *Figure 6*. Ceramic and plastic dual-in-line packages are available for critical applications with guard pins adjacent to the inputs both to facilitate board layout and to reduce package leakage. These guard pins are not internally connected.



TL/H/7478-8

Bottom View

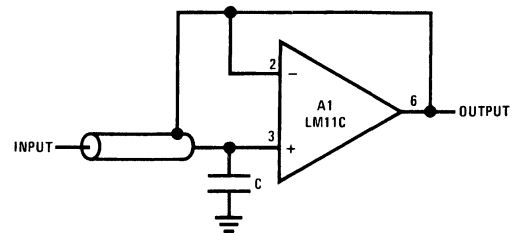
Figure 6. Input guarding can drastically reduce surface leakage. Layout for metal can is shown here. Guarding both sides of board is required. Bulk leakage reduction is less and depends on guard ring width.

signal cables

It is advisable to locate high impedance amplifiers as close as possible to the signal source. But sometimes connecting lines cannot be avoided. Coaxially shielded cables with good insulation are recommended. Polyethylene or virgin (not reconstituted) Teflon is best for critical applications.

In addition to potential insulation problems, even short cable runs can reduce bandwidth unacceptably with high source resistances. These problems can be largely avoided by bootstrapping the cable shield. This is shown for the follower connection in *Figure 7*. In a way, bootstrapping is positive feedback; but instability can be avoided with a small capacitor on the input.

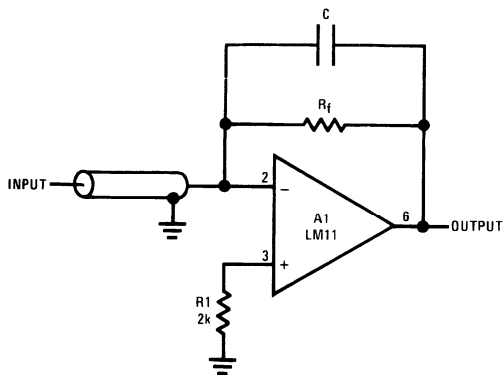
Cable Bootstrapping



TL/H/7478-9

Figure 7. Bootstrapping input shield for a follower reduces cable capacitance, leakage and spurious voltages from cable flexing. Instability can be avoided with small capacitor on input.

With the summing amplifier, the cable shield is simply grounded, with the summing node at virtual ground. A small feedback capacitor may be required to insure stability with the added cable capacitance. This is shown in *Figure 8*.



TL/H/7478-10

Figure 8. With summing amplifier, summing node is at virtual ground so input shield is best grounded. Small feedback capacitor insures stability.

An inverting amplifier with gain may require a separate follower to drive the cable shield if the influence of the capacitance, between shield and ground, on the feedback network cannot be accounted for.

High impedance circuits are also prone to mechanical noise (microphonics) generated by variable stray capacitances. A capacitance variation will generate a noise voltage given by

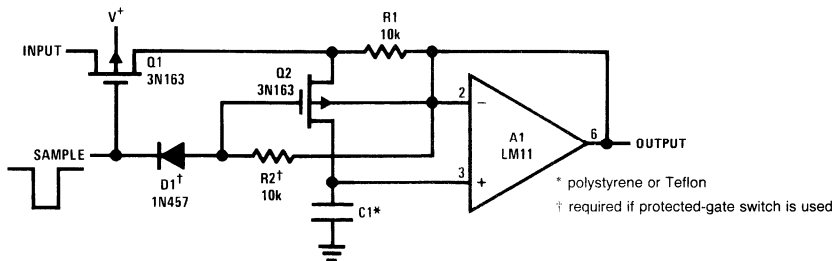
$$e_n = \frac{\Delta C}{C} V,$$

where V is the dc bias on the capacitor. Therefore, the wiring and components connected to sensitive nodes should be mechanically rigid.

This is also a problem with flexible cables, in that bending the cable can cause a capacitance change. Bootstrapping the shield nearly eliminates dc bias on the cable, minimizing the voltage generated. Another problem is electrostatic charge created by friction. Graphite lubricated Teflon cable will reduce this.

switch leakage

Semiconductor switches with leakage currents as low as the bias current of the LM11 are not generally available when operation much above 50°C is involved. The sample-and-hold circuit in *Figure 9* shows a way around this problem. It is arranged so that switch leakage does not reach the storage capacitor.



TL/H/7478-11

Figure 9. Switch leakage in this sample and hold does not reach storage capacitor. If Q2 has an internal gate-protection diode, D1 and R2 must be included to remove bias from its junction during hold.

Isolating leakage current requires that two switches be connected in series. The leakage of the first, Q1, is absorbed by R1 so that the second, Q2, only has the offset voltage of the op amp across its junctions. This can be expected to reduce leakage by at least two orders of magnitude. Adjusting the op amp offset to zero at the maximum operating temperature will give the ultimate leakage reduction, but this is not usually required with the LM11.

MOS switches with gate-protection diodes are preferred in production situations as they are less sensitive to damage from static charges in handling. If used, D1 and R2 should be included to remove bias from the protection diode during hold. This may not be required in all cases but is advised since leakage from the protection diode depends on the internal geometry of the switch, something the designer does not normally control.

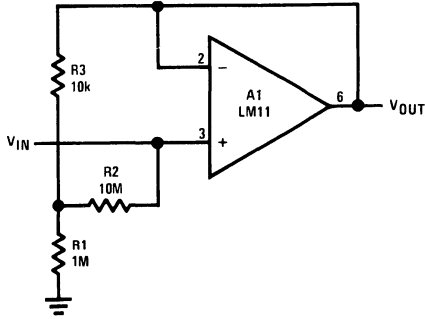
A junction FET could be used for Q1 but not Q2 because there is no equivalent to the enhancement mode MOSFET. The gate of a J-FET must be reverse biased to turn it off, and leakage on its output cannot be avoided.

high-value resistors

Using op amps at very high impedance levels can require unusually large resistor values. Standard precision resistors are available up to 10 MΩ. Resistors up to 1 GΩ can be obtained at a significant cost premium. Larger values are quite expensive, physically large and require careful handling to avoid contamination. Accuracy is also a problem. There are techniques for raising effective resistor values in op amp circuits. In theory, performance is degraded; in practice, this may not be the case.

With a buffer amplifier, it is sometimes desirable to put a resistor to ground on the input to keep the output under control when the signal source is disconnected. Otherwise it will saturate. Since this resistor should not load the source, very large values can be required in high-impedance circuits.

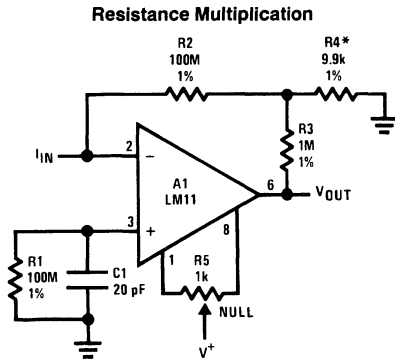
Figure 10 shows a voltage follower with a 1 GΩ input resistance built using standard resistor values. With the input disconnected, the input offset voltage is multiplied by the same factor as R2; but the added error is small because the offset voltage of the LM11 is so low. When the input is connected to a source less than 1 GΩ, this error is reduced. For an ac-coupled input, a second 10 MΩ resistor could be connected in series with the inverting input to virtually eliminate bias current error; bypassing it would give minimal noise.



TL/H/7478-12

Figure 10. Follower input resistance is 1 GΩ. With the input open, offset voltage is multiplied by 100, but the added error is not great because the op amp offset is low.

The voltage-to-current converter in *Figure 11* uses a similar method to obtain the equivalent of a 10 GΩ feedback resistor. Output offset is reduced because the error can be made dependent on offset current rather than bias current. This would not be practical with large value resistors because of cost, particularly for matched resistors, and because the summing node would be offset several hundred millivolts from ground. In *Figure 11*, this offset is limited to several millivolts. In addition, the output can be nulled with the usual balance potentiometer. Further, gain trimming is easily done.



TL/H/7478-13

Figure 11. Equivalent feedback resistance is 10 GΩ, but only standard resistors are used. Even though the offset voltage is multiplied by 100, output offset is actually reduced because error is dependent on offset current rather than bias current. Voltage on summing junction is less than 5 mV.

This circuit would benefit from lower offset current than can be tested and guaranteed with automatic test equipment. But there should be no problem in selecting a device for critical applications.

capacitors

Op amp circuits impose added requirements on capacitors, and this is compounded with high-impedance circuitry. Fre-

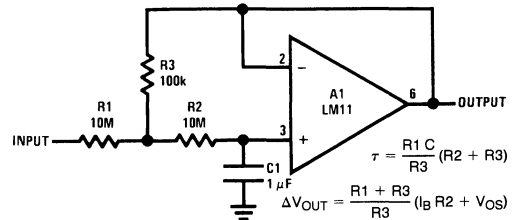
quency shaping and charge measuring circuits require control of the capacitor tolerance, temperature drift and stability with temperature cycling. For smaller values, NPO ceramic is best while a polystyrene-polycarbonate combination gives good results for larger values over a -10°C to 85°C range.

Dielectric absorption can also be a problem. It causes a capacitor that has been quick-charged to drift back toward its previous state over many milliseconds. The effect is most noticeable in sample-and-hold circuits. Polystyrene, Teflon and NPO ceramic capacitors are most satisfactory in this regard. Choice depends mainly on capacitance and temperature range.

Insulation resistance can clearly become a problem with high-impedance circuitry. Best performer is Teflon, with polystyrene being a good substitute below 85°C . Mylar capacitors should be avoided, especially where higher temperatures are involved.

Temperature changes can also alter the terminal voltage of a capacitor. Because thermal time constants are long, this is only a problem when holding intervals are several minutes or so. The effect is reported to be as high as $10\text{ mV}/^{\circ}\text{C}$, but Teflon capacitors that hold it to $0.5\text{ mV}/^{\circ}\text{C}$ are available*.

An op amp with lower bias current can ease capacitor problems, primarily by reducing size. This is obvious with a sample-and-hold because the capacitor value is determined by the hold interval and the amplifier bias current. The circuit in *Figure 12* is another example. An RC time constant of more than a quarter hour is obtained with standard component values. Even when such long time constants are not required, reducing capacitor size to where NPO ceramics can be used is a great aid in precision work.



TL/H/7478-14

Figure 12. This circuit multiplies RC time constant to 1000 seconds and provides low output impedance. Cost is lowered because of reduced resistor and capacitor values.

conclusions

A low cost IC op amp has been described that not only has low offset voltage but also advances the state of the art in reducing input current error, particularly at elevated temperatures. Designers of industrial as well as military/space equipment can now work more freely at high impedance levels.

Although high-impedance circuitry is more sensitive to board leakages, wiring capacitances, stray pick-up and leakage in other components, it has been shown how input guarding, bootstrapping, shielding and leakage isolation can largely eliminate these problems.

*Component Research Co., Inc., Santa Monica, California.

acknowledgment

The author would like to acknowledge the assistance of the staff at National Semiconductor in implementing this design and sorting out the application problems. Discussions with Bob Dobkin, Bob Pease, Carl Nelson and Mineo Yamatake have been most helpful.

appendix

super-gain techniques

Super-gain transistors are not new, having been developed for the LM102/LM110 voltage followers in 1967 and later used on the LM108 general-purpose op amp. They are similar to regular transistors, except that they are diffused for high current gains (2,000–10,000) at the expense of breakdown voltage. A curve-tracer display of a typical device is shown in *Figure A1*. In an IC, super-gain transistors can be made simultaneously with standard transistors by including a second, light base predeposition that is diffused less deeply.

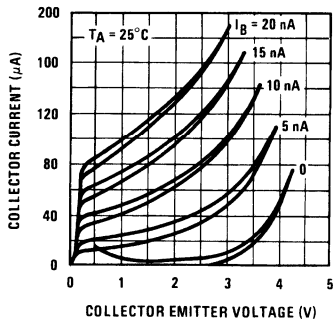
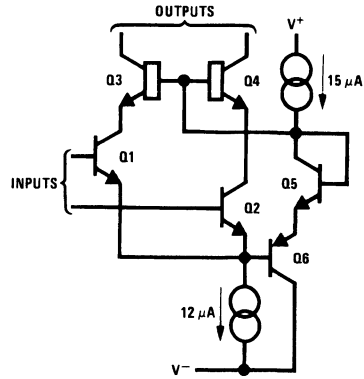


Figure A1. curve tracer display of a super-gain transistor

TL/H/7478-15

Super-gain transistors can be connected in cascode with regular transistors to form a composite device with both high gain and high breakdown. The simplified schematic of the LM108 input stage in *Figure A2* shows how it is done. A common base pair, Q3 and Q4, is bootstrapped to the input transistors, Q1 and Q2, so that the latter are operated at nearly zero collector-base voltage, no matter what the input common-mode. The regular NPN transistors are distinguished by drawing them with wider base regions.

Operating the input transistors at very low collector-base voltage has the added advantage of drastically reducing collector-base leakage. In this configuration bipolar transistors are affected little by the leakage currents that limit performance of FET amplifiers.



TL/H/7478-16

Figure A2. A bootstrapped input stage

***See Addendum to this Application Note at the End of Application Note 242.**

Applying a New Precision Op Amp

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Application Note 242



Abstract: A new bipolar op amp design has advanced the state of the art by reducing offset voltage and bias current errors. Its characteristics are described here, indicating an ultimate input resolution of $10\ \mu\text{V}$ and $1\ \text{pA}$ under laboratory conditions. Practical circuits for making voltmeters, ammeters, differential instrumentation amplifiers and a variety of other designs that can benefit from the improved performance are covered in detail. Methods of coupling the new device to existing fast amplifiers to take advantage of the best characteristics of both, even in follower applications, are explored.

Introduction

A low cost, mass-produced op amp with electrometer-type input currents combined with low offset voltage and drift is now available. Designated the LM11, this IC can minimize production problems by providing accuracy without adjustments, even in high-impedance circuitry. On the other hand, if pushed to its full potential, what has been impossible in the past becomes entirely practical.

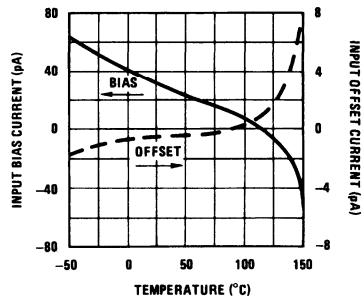
Significantly, the LM11 is not restricted to commercial and industrial use. Devices can be completely specified over a -55°C to $+125^\circ\text{C}$ range. Preliminary data indicates that reliability is the same as standard ICs qualified for military and space applications.

The essential details of the design along with an introduction to the peculiarities of high-impedance circuits have been presented elsewhere.* This will be expanded here. Practical circuitry that reduces effective bias current for those applications where performance cannot be made dependent on offset current are described. In addition, circuits combining the DC characteristics of the new part with the AC performance of existing fast amplifiers will be shown. This will be capped with a number of practical designs to provide some perspective into what might be done.

dc errors

Barring the use of chopper or reset stabilization, the best offset voltage, drift and long-term stability are obtained using bipolar transistors for the op amp input stage. This has been done with the LM11. On-wafer trimming further improves performance. Typically, a $100\ \mu\text{V}$ offset with $1\ \mu\text{V}/^\circ\text{C}$ drift results.

Transistors with typical current gains of 5000 have been used in the manufacture of the LM11. The input stage employs a Darlington connection that has been modified so that offset voltage and drift are not degraded. The typical input currents, plotted in Figure 1, demonstrate the value of the approach.



TL/H/7479-1

Figure 1. Below 100°C , bias current varies almost linearly with temperature. This means that simple circuitry can be used for compensation. Offset current is unusually low.

The offset current of this op amp is so low that it cannot be measured on existing production test equipment. Therefore, it probably cannot be specified tighter than $10\ \text{pA}$. For critical applications, the user should have little difficulty in selecting to a tighter limit.

The bias current of the LM11 equals that of monolithic FET amplifier at 25°C . Unlike FETs, it does not double every 10°C . In fact, the drift over a -55°C to $+125^\circ\text{C}$ temperature range is about the same as that of a FET op amp during normal warm up.

Other characteristics are summarized in Table I. It can be seen that the common-mode rejection, supply-voltage rejection and voltage gain are high enough to take full advantage of the low offset voltage. The unspectacular $0.3\text{V}/\mu\text{s}$ slew rate is balanced by the $300\ \mu\text{A}$ current drain.

*R. J. Widlar, "Working with High Impedance Op Amps", National Semiconductor AN-241.

Table I. Typical characteristics of the LM11 for $T_j = 25^\circ\text{C}$ and $V_S = \pm 15\text{V}$. Operation is specified down to $V_S = \pm 2.5\text{V}$.

Parameter	Conditions	Value
Input Offset Voltage		100 μV
Input Offset Current		500 fA
Input Bias Current		25 pA
Input Noise Voltage	$0.01 \text{ Hz} \leq f \leq 10 \text{ Hz}$	8 μVpp
Input Noise Current	$0.01 \text{ Hz} \leq f \leq 10 \text{ Hz}$	1 pApp
Long Term Stability	$T_j = 25^\circ\text{C}$	10 μV
Offset Voltage Drift	$-55^\circ\text{C} \leq T_j \leq 125^\circ\text{C}$	1 $\mu\text{V}/^\circ\text{C}$
Offset Current Drift	$-55^\circ\text{C} \leq T_j \leq 125^\circ\text{C}$	20 fA/ $^\circ\text{C}$
Bias Current Drift	$-55^\circ\text{C} \leq T_j \leq 125^\circ\text{C}$	500 fA/ $^\circ\text{C}$
Voltage Gain	$V_{\text{OUT}} = \pm 12\text{V}$, $I_{\text{OUT}} = \pm 0.5 \text{ mA}$	1,200V/mV
	$V_{\text{OUT}} = \pm 12\text{V}$, $I_{\text{OUT}} = \pm 2 \text{ mA}$	300V/mV
Common-Mode Rejection	$-12.5\text{V} \leq V_{\text{CM}} \leq 14\text{V}$	130 dB
Supply-Voltage Rejection	$\pm 2.5\text{V} \leq V_S \leq \pm 20\text{V}$	118 dB
Slew Rate		0.3V/ μs
Supply Current		300 μA

As might be expected, the low bias currents were obtained with some sacrifice in noise. But the low frequency noise voltage is still a bit less than a FET amplifier and probably more predictable. The latter is important because this noise cannot be tested in production. Long term measurements have not indicated any drift in excess of the noise. This is not the case for FETs.

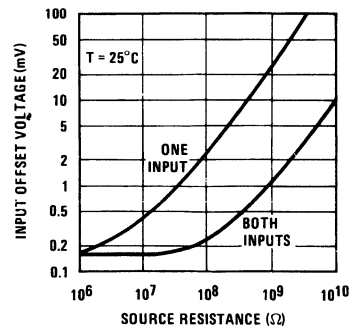
It is worthwhile noting that the drift of offset voltage and current is low enough that DC accuracy is noise limited in room-temperature applications.

bias current compensation

The LM11 can operate from $M\Omega$ source resistances with little increase in the equivalent offset voltage, as can be seen in Figure 2. This is impressive considering the low initial offset voltage. The situation is much improved if the design can be configured so that the op amp sees equal resistance on the two inputs. However, this cannot be done with

all circuits. Examples are integrators, sample and holds, logarithmic converters and signal-conditioning amplifiers. And even though the LM11 bias current is low, there will be those applications where it needs to be lower.

Referring back to Figure 1, it can be seen that the bias current drift is essentially linear over a -50°C to $+100^\circ\text{C}$ range. This is a deliberate consequence of the input stage design. Because of it, relatively simple circuitry can be used to develop a compensating current.

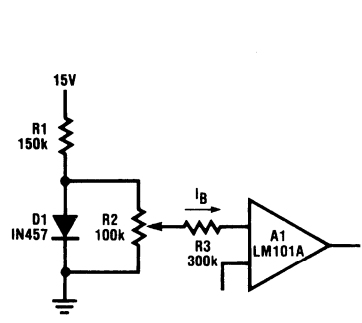


TL/H/7479-2

Figure 2. The LM11 operates from $M\Omega$ source resistances with little DC error. With equal source resistances, accuracy is essentially limited by low frequency current noise.

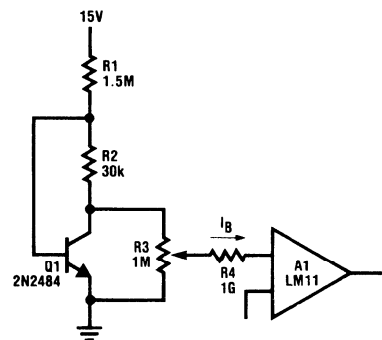
Bias current compensation is not new, but making it effective with even limited temperature excursions has been a problem. An early circuit suggested for bipolar ICs is shown in Figure 3a. The compensating current is determined by the diode voltage. This does not vary as rapidly with temperature as bias current nor does it match the usual non-linearities.

With the improved circuit in Figure 3b, the temperature coefficient can be increased by using a transistor and including R2. The drop across R2 is nearly constant with temperature. The voltage delivered to the potentiometer has a 2.2 mV/ $^\circ\text{C}$ drift while its magnitude is determined by R2. Thus, as long as the bias current varies linearly with temperature, a value for R2 can be found to effect compensation.



TL/H/7479-3

a. original circuit

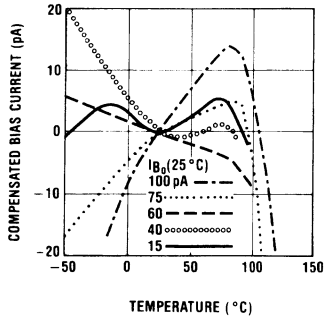


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b. improved version

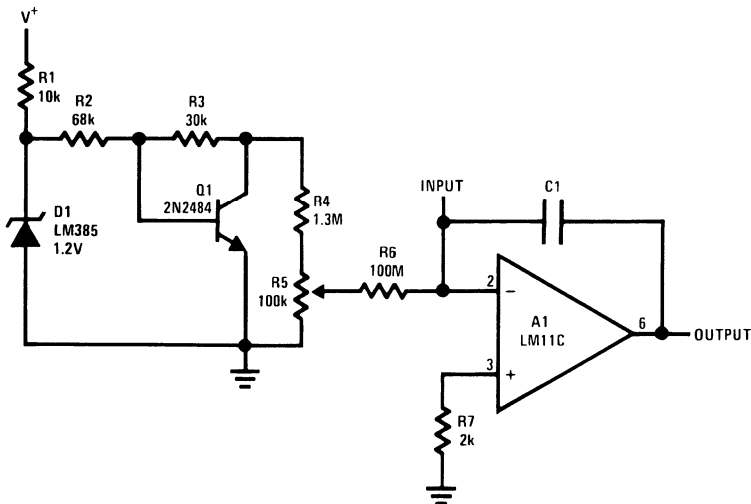
Figure 3. Bias-current compensation. With the improved version, the temperature coefficient of the compensating current can be varied with R2. It is effective only if bias current has linear, negative temperature coefficient.

In production, altering resistors based on temperature testing is to be avoided if at all possible. Therefore, the results that can be obtained with simple nulling at room temperature and a fixed value for R2 are of interest. Figure 4 gives this data for a range of parts with different initial bias currents. This was obtained from pre-production and initial-production runs. The bias current variations were the result of both h_{FE} variations and changes in internal operating currents and represent the worst as well as best obtained. They are therefore considered a realistic estimate of what would be encountered among various production lots.



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Figure 4. Compensated bias current for five representative units with a range of initial bias currents. The circuit in Figure 3b was used with balancing at 25°C. High drift devices could be improved further by altering R2.



TL/H/7479-6

Figure 5. Bias current compensation for use with unregulated supplies. Reference voltage is available for other circuitry.

Little comment need be made on these results, except that the method is sufficiently predictable that another factor of five reduction in worst case bias current could be made by altering R2 based on the results of a single temperature run.

One disadvantage of the new circuit is that it is more sensitive to supply variations than the old. This is no problem if the supplies are regulated to 1%. But with worst regulation it suffers because, with R2, the transistor no longer functions as a regulator and because much tighter compensation is obtained.

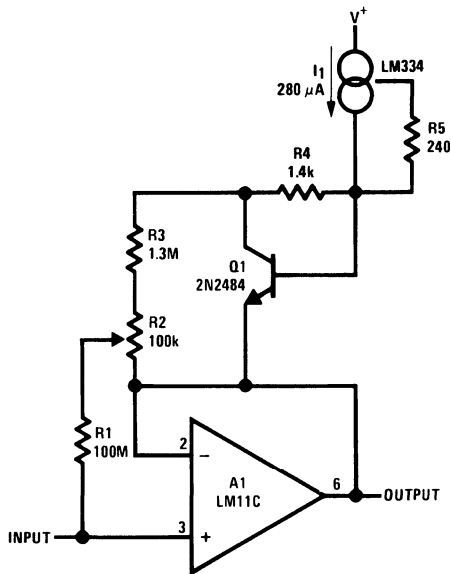
The circuit in Figure 5 uses pre-regulation to solve this problem. The added reference diode has a low breakdown so that the minimum operating voltage of the op amp is unrestricted. Because of the low breakdown, the drop across R3 can no longer be considered constant. But it will vary linearly with temperature, so this is of no consequence. The fact that this reference can be used for other functions should not be overlooked because a regulated voltage is frequently required in designs using op amps.

In Figure 5, a divider is used so that the resistor feeding the compensating current to the op amp can be reduced. There will be an error current developed for any offset voltage change across R6. This should not be a problem with the LM11 because of its low offset voltage. But for tight compensation, mismatch in the temperature characteristics of R4 and R5 must be considered.

Bias current compensation is more difficult for non-inverting amplifiers because the common-mode voltage varies. With a voltage follower, everything can be bootstrapped to the output and powered by a regulated current source, as shown in *Figure 6*. The LM334 is a temperature sensor. It regulates against voltage changes and its output varies linearly with temperature, so it fits the bill.

Although the LM334 can accommodate voltage changes fast enough to work with the LM11, it is not fast enough for the high-speed circuits to be described. But compensation can still be obtained by using the zener diode pre-regulator bootstrapped to the output and powered by either a resistor or FET current source. The LM385 fits well here because both the breakdown voltage and minimum operating current are low.

With ordinary op amps, the collector base voltage of the input transistors varies with the common-mode voltage. A 50% change in bias current over the common-mode range is not unusual, so compensating the bias current of a follow-



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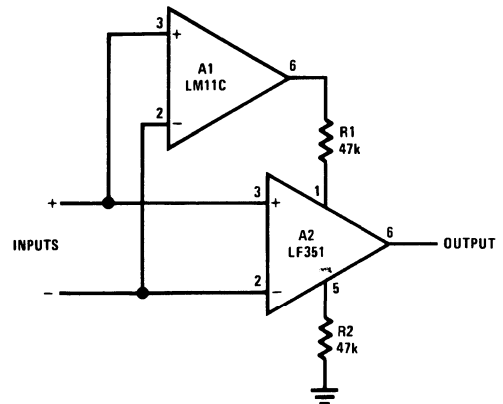
Figure 6. This circuit shows how bias current compensation can be used on a voltage follower.

er has limited value. However, the bootstrapped input stage of the LM11 reduces this to about 2 pA for a $\pm 20V$ common-mode swing, giving a $2 \times 10^{13}\Omega$ common-mode input resistance.

fast amplifiers

A precision DC amplifier, although slow, can be used to stabilize the offset voltage of a less precise fast amplifier. As shown in *Figure 7*, the slow amplifier senses the voltage across the input terminals and supplies a correction signal to the balance terminals of the fast amplifier. The LM11 is particularly interesting in this respect as it does not degrade the input bias current of the composite even when the fast amplifier has a FET input.

Surprisingly, with the LM11, this will work for both inverting and non-inverting connections because its common-mode slew recovery is a lot faster than that of the main loop. This was accomplished, even with circuitry running under 100 nA, by proper clamping and by bootstrapping of internal stray capacitances.



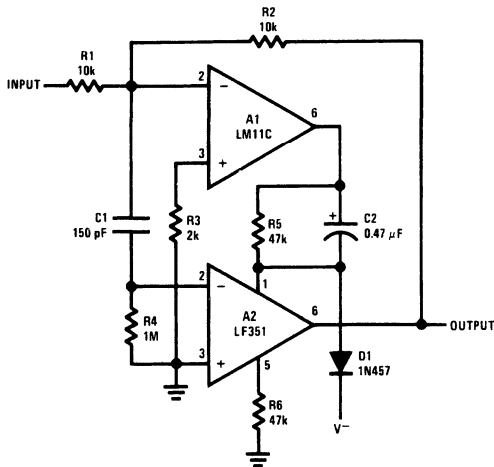
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Figure 7. A slow amplifier can be used to null the offset of a fast amplifier.

An optimized circuit for the inverting amplifier connection is shown in *Figure 8*. The LM11 is DC coupled to the input and drives the balance terminals of the fast amplifier. The fast amplifier is AC coupled to the input and drives the output. This isolates FET leakage from the input circuitry.

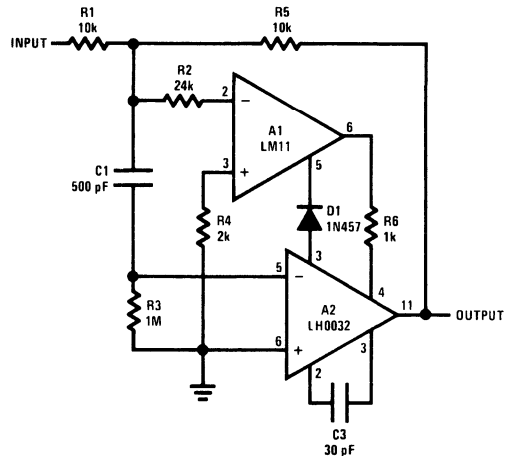
As can be seen, the method of coupling into the balance terminals will vary depending on the internal configuration of the fast amplifier. If the quiescent voltage on the balance terminals is beyond the output swing of the LM11, a differential coupling must be used, as in *Figure 8a*. A lead capacitor, C2, reduces the AC swing required at the LM11 output. The clamp diode, D1, insures that the LM11 does not overdrive the fast amplifier in slew.

If the quiescent voltage on the balance terminals is such that the LM11 can drive directly, the circuit in *Figure 8b* can be used. A clamp diode from the other balance terminal to internal circuitry of the LM11 keeps the output from swinging too far from the null value, and a resistor may be required in series with its output to insure stability.



TL/H/7479-9

a. with standard BI-FET

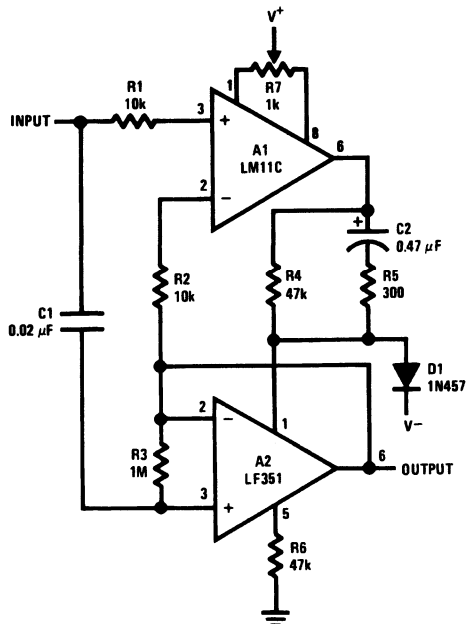


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b. with fast hybrid

Figure 8. These inverters have bias current and offset voltage of LM11 along with speed of the FET op amps. Open loop gain is about 140 dB and settling time to 1 mV about 8 μ s. Excess overload-recovery delay can be eliminated by directly coupling the FET amplifier to summing node.

A voltage-follower connection is given in *Figure 9*. The coupling circuitry is similar, except that R5 was added to eliminate glitches in slew. Overload involves driving the fast amplifier outside its common-mode range and should be avoided by limiting the input. Thus, AC coupling the fast amplifier is less a problem. But the repetition frequency of the input signal must also be limited to 10 kHz for $\pm 10V$ swing. Higher frequencies produce a DC error, believed to result from rectification of the input signal by the voltage sensitive input capacitance of the FET amplifier used. A fast bipolar amplifier like the LM118 should work out better in this respect. To avoid confusion, it should be emphasized that this problem is related to repetition frequency rather than rise time.



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Figure 9. Follower has 10 μs settling to 1 mV, but signal repetition frequency should not exceed 10 kHz if the FET amplifier is AC coupled to input. The circuit does not behave well if common-mode range is exceeded.

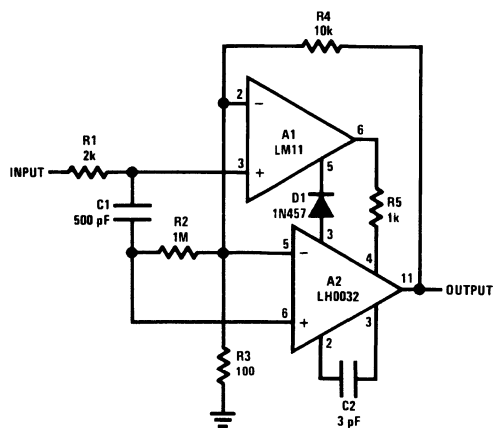
A precision DC amplifier with a 100 MHz gain-bandwidth product is shown in *Figure 10*. It has reasonable recovery ($\sim 7 \mu s$) from a 100% overload; but beyond that, AC coupling to the fast amplifier causes problems. Alone, the gain error and thermal feedback of the LH0032 are about 20 mV, input referred, for $\pm 10V$ output swing. Adding the LM11 reduces this to microvolts.

picoammeter

Ideally, an ammeter should read zero with no input current and have no voltage drop across its inputs even with full-scale deflection. Neither should spurious indications nor inaccuracy result from connecting it to a low impedance. Meeting all these requirements calls for a DC amplifier, and one in which both bias current and offset voltage are controlled.

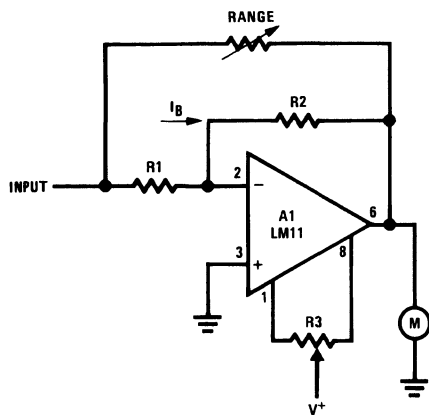
The summing amplifier connection is best for measuring current, because it minimizes the voltage drop across the

input terminals. However, when the inputs are shorted, the output state is indeterminate because of offset voltage. Adding degeneration as shown in *Figure 11* takes care of this problem. Here, R2 is the feedback resistor for the most sensitive range, while R1 is chosen to get the meter deflection out of the noise with a shorted input. Adding the range resistor, as shown, does not affect the degeneration, so that there is minimal drop across the input for full-scale on all ranges.



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Figure 10. This 100X amplifier has small and large signal bandwidth of 1 MHz. The LM11 greatly reduces offset voltage, bias current and gain error. Eliminating long recovery delay for greater than 100% overload requires direct coupling of A2 to input.



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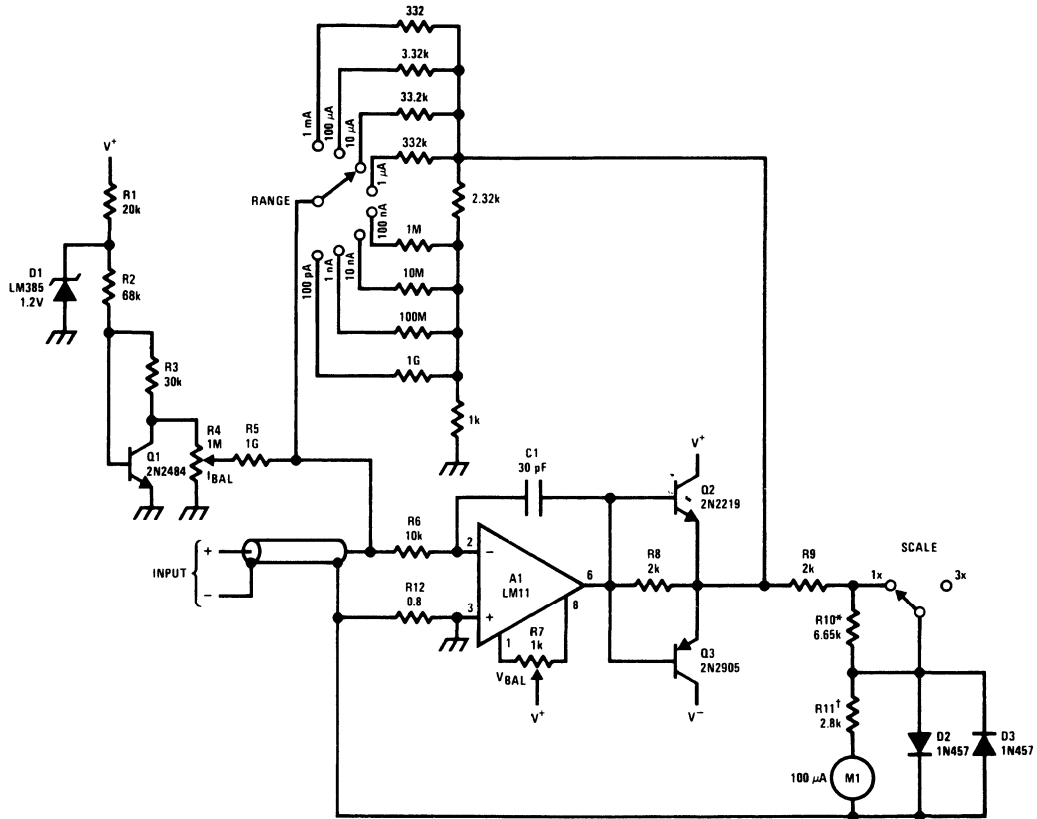
Figure 11. An ammeter that has constant voltage drop across its input at full-scale, no matter what the range. It can have a reasonably-behaved output even with shorted inputs, yet a maximum drop of ten times the op amp noise voltage.

The complete meter circuit in *Figure 12* uses a different scheme. A floating supply is available so that the power ground and the signal ground can be separated with R12. At full-scale, the meter current plus the measured current flow through this resistor, establishing the degeneration. This method has the advantage of allowing even-value range resistors on the lower ranges but increases degeneration as the measured current approaches the meter current.

Bias-current compensation is used to increase the meter sensitivity so there are two zeroing adjustments; current balancing, that is best done on the most sensitive range where it is needed, and voltage balancing that should be done with the inputs shorted on a range below 100 μ A, where the degeneration is minimal.

With separate grounds, error could be made dependent on offset current. This would eliminate bias-current compensation at the expense of more complicated range switching.

The op amp input has internal, back-to-back diodes across it, so R6 is added to limit current with overloads. This type of protection does not affect operation and is recommended whenever more than 10 mA is available to the inputs. The output buffers are added so that input overloads cannot drag down the op amp output on the least-sensitive range, giving a false meter indication. These would not be required if the maximum input current did not approach the output current limit of the op amp.



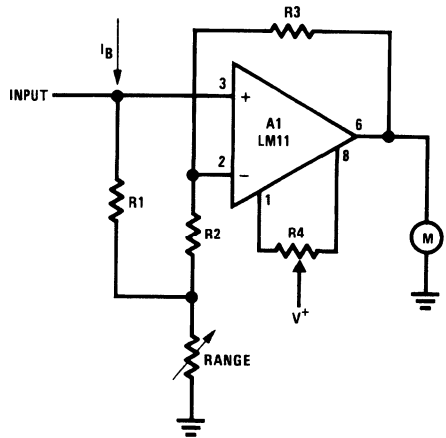
TL/H/7479-14

Figure 12. Current meter ranges from 100 pA to 3 mA, full-scale. Voltage across input is 100 μ V at lower ranges rising to 3 mV at 3 mA. Buffers on op amp are to remove ambiguity with high-current overload. Output can also drive DVM or DPM.

millivoltmeter

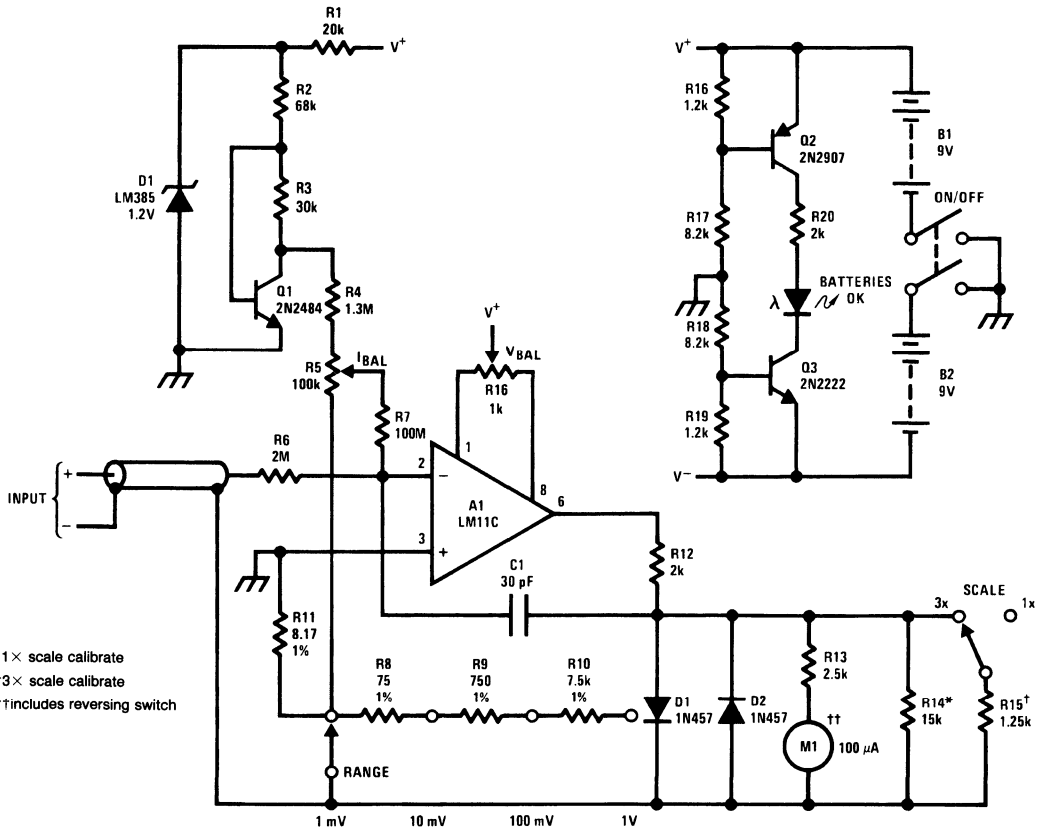
An ideal voltmeter has requirements analogous to those discussed for the ammeter, and *Figure 13* shows a circuit that will satisfy them. In the most-sensitive position, the range resistor is zero and the input resistance equals R1. As voltage measurement is desensitized by increasing the range resistor, the input resistance is also increased, giving the maximum input resistance consistent with zero stability with the input open. Thus, at full-scale, the source will be loaded by whatever multiple of the noise current is required to give the desired open-input zero stability.

This technique is incorporated into the voltmeter circuit in *Figure 14* to give a 100 MΩ input resistance on the 1 mV scale rising to 300 GΩ on the 3V scale. The separation of power and signal grounds has been used here to simplify bias-current compensation. Otherwise, a separate op amp would be required to bootstrap the compensation to the input.



TL/H/7479-15

Figure 13. This voltmeter has constant full-scale loading independent of range. This can be only ten times the noise current, yet the output will be reasonably behaved for open input.

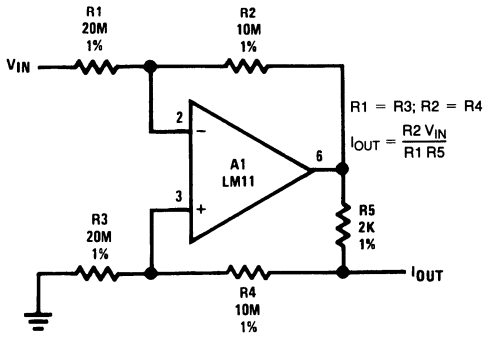


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Figure 14. High input impedance millivoltmeter. Input current is proportional to input voltage, about 10 pA at full-scale. Reference could be used to make direct reading linear ohmmeter.

The input resistor, R6, serves two functions. First, it protects the op amp input in the event of overload. Second, it insures that an overload will not give a false meter indication until it exceeds a couple hundred volts.

Since the reference is bootstrapped to the input, this circuit is easily converted into a linear, direct-reading ohmmeter. A resistor from the top of D1 to the input establishes the measurement current so that the voltage drop is proportional to the resistance connected across the input.



TL/H/7479-17

Figure 15. Output resistance of this voltage/current converter depends both on high value feedback resistors and their matching.

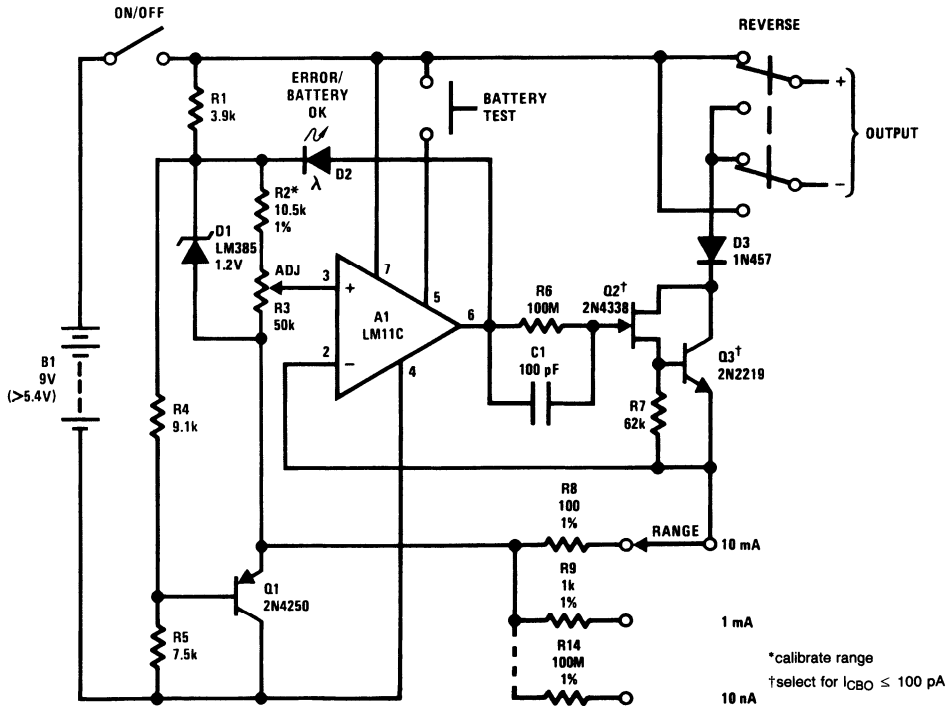
current sources

The classical op amp circuit for voltage-to-current conversion is shown in Figure 15. It is presented here because the output resistance is determined by both the matching and the value of the feedback resistors. With the LM11, these resistors can be raised while preserving DC stability.

While the circuit in Figure 15 can provide bipolar operation, better performance can be obtained with fewer problems if a unipolar output is acceptable. A complete, battery-powered current source suitable for laboratory use is given in Figure 16 to illustrate this approach. The op amp regulates the voltage across the range resistors at a level determined by the voltage on the arm of the calibrated potentiometer, R3. The voltage on the range resistors is established by the current through Q2 and Q3, which is delivered to the output.

The reference diode, D1, determines basic accuracy. Q1 is included to insure that the LM11 inputs are kept within the common-mode range with diminishing battery voltage. A light-emitting diode, D2, is used to indicate output saturation. However, this indication cannot be relied upon for output-current settings below about 20 nA unless the value of R6 is increased. The reason is that very low currents can be supplied to the range resistors through R6 without developing enough voltage drop to turn on the diode.

If the LED illuminates with the output open, there is sufficient battery voltage to operate the circuit. But a battery-test switch is also provided. It is connected to the base of the op amp output stage and forces the output toward V⁺.



TL/H/7479-18

Figure 16. Precision current source has 10 nA to 10 mA ranges with output compliance of 30V to -5V. Output current is fully adjustable on each range with a calibrated, ten-turn potentiometer. Error light indicates output saturation.

Bias current compensation is not used because low-range accuracy is limited by the leakage currents of Q2 and Q3. As it is, these parts must be selected for low leakage. This should not be difficult because the leakage specified is determined by test equipment rather than device characteristics. It should be noted in making substitutions that Q2 was selected for low pinch-off voltage and that Q3 may have to dissipate 300 mW on the high-current range. Heating Q3 on the high range could increase leakage to where the circuit will not function for a while when switched to the low range.

logarithmic converter

A logarithmic amplifier that can operate over an eight-decade range is shown in Figure 17. Naturally, bias current compensation must be used to pick up the low end of this range. Leakage of the logging transistors is not a problem as long as Q1A is operated at zero collector-base voltage. In the worst case, this may require balancing the offset voltage of A1. Non-standard frequency compensation is used on A1 to obtain fairly uniform response time, at least at the high end of the range. The low end might be improved by optimizing C1. Otherwise, the circuit is standard.

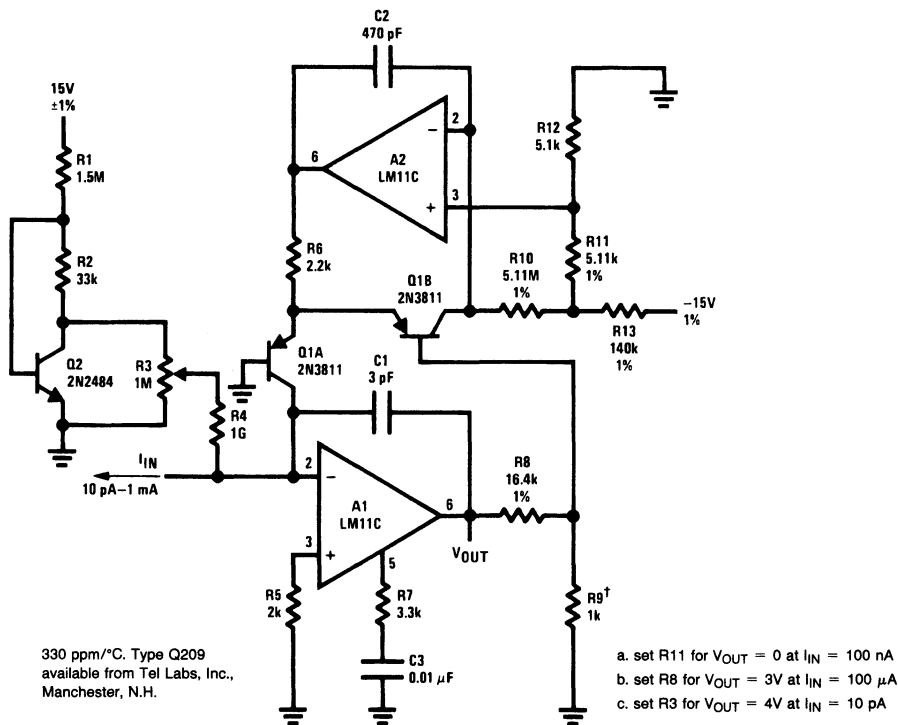


Figure 17. Unusual frequency compensation gives this logarithmic converter a 100 μ s time constant from 1 mA down to 100 nA, increasing from 200 μ s to 200 ms from 10 nA to 10 pA. Optional bias current compensation can give 10 pA resolution from -55° C to $+100^{\circ}$ C. Scale factor is 1V/decade and temperature compensated.

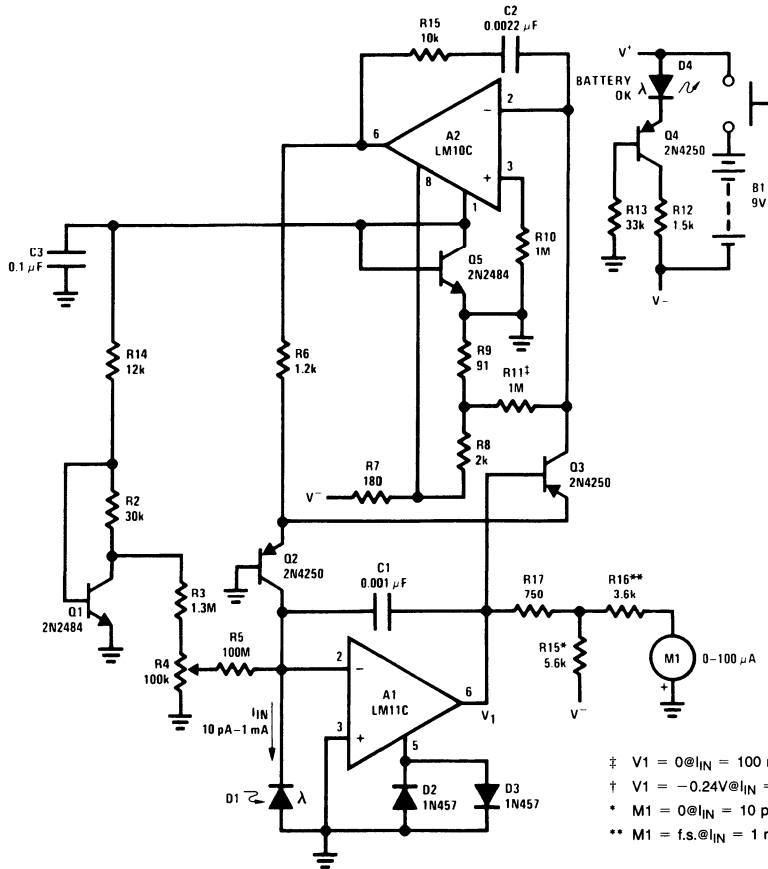
light meter

This logging circuit is adapted to a battery-powered light meter in Figure 18. An LM10, combined op amp and reference, is used for the second amplifier and to provide the regulated voltage for offsetting the logging circuit and powering the bias current compensation. Since a meter is the output indicator, there is no need to optimize frequency compensation. Low-cost single transistors are used for logging since the temperature range is limited. The meter is protected from overloads by clamp diodes D2 and D3.

Silicon photodiodes are more sensitive to infrared than visible light, so an appropriate filter must be used for photography. Alternately, gallium-arsenide-phosphide diodes with suppressed IR response are becoming available.

differential amplifiers

Many instrumentation applications require the measurements of low-level signals in the presence of considerable ground noise. This can be accomplished with a differential amplifier because it responds to the voltage between the inputs and rejects signals between the inputs and ground.

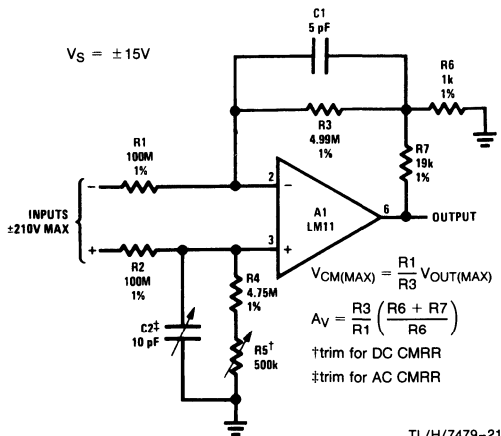


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Figure 18. Light meter has eight-decade range. Bias current compensation can give input current resolution of better than $\pm 2 \text{ pA}$ over 15°C to 55°C .

Figure 19 shows the classic op amp differential amplifier connection. It is not widely used because the input resistance is much lower than alternate methods. But when the input common-mode voltage exceeds the supply voltage for the op amp, this cannot be avoided. At least with the LM11, large feedback resistors can be used to reduce loading without affecting DC accuracy. The impedances looking into the two inputs are not always the same. The values given equalize them for common-mode signals because they are usually larger. With single-ended inputs, the input resistance on the inverting input is R_1 , while that on the non-inverting input is the sum of R_2 , R_4 and R_5 .

Provision is made to trim the circuit for maximum DC and AC common-mode rejection. This is advised because well matched high-value resistors are hard to come by and because unbalanced stray capacitances can cause severe deterioration of AC rejection with such large values. Particular attention should be paid to resistor tracking over temperature as this is more of a problem with high-value resistors. If higher gain or gain trim is required, R_6 and R_7 can be added.



TL/H/7479-21

Figure 19. This differential amplifier handles high input voltages. Resistor mismatches and stray capacitances should be balanced out for best common-mode rejection.

The simplest connection for making a high-input-impedance differential amplifier using op amps is shown in *Figure 20*. Its main disadvantage is that the common-mode signal on the inverting input is delayed by the response of A1 before being delivered to A2 for cancellation. A selected capacitor across R1 will compensate for this, but AC common-mode rejection will deteriorate as the characteristics of A1 vary with temperature.

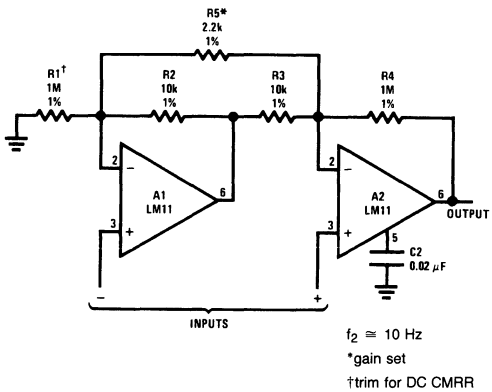


Figure 20. Two-op-amp instrumentation amplifier has poor AC common-mode rejection. This can be improved at the expense of differential bandwidth with C2.

When slowly varying differential signals are of interest, the response of A2 can be rolled off with C2 to reduce the sensitivity of the circuit to high frequency common-mode signals. If single-resistor gain setting is desired, R5 can be added. Otherwise, it is unnecessary.

A full-blown differential amplifier with extremely high input impedance is shown in *Figure 21*. Gain is fixed at 1000, but it can be varied with R10. Differential offset balancing is provided on both input amplifiers by R18.

The AC common-mode rejection is dependent on how well the frequency characteristics of A2 and A3 match. This is a far better situation than encountered with the previous circuit. When AC rejection must be optimized, amplifier differences as well as the effects of unbalanced stray capacitances can be compensated for with a capacitor across R13 or R14, depending on which side is slower. Alternately, C1 can be added to control the differential bandwidth and make AC common-mode rejection less dependent on amplifier matching. The value shown gives approximately 100 Hz differential bandwidth, although it will vary with gain setting.

A separate amplifier is used to drive the shields of the input cables. This reduces cable leakage currents and spurious signals generated from cable flexing. It may also be required to neutralize cable capacitance. Even short cables can attenuate low-frequency signals with high enough source resistance. Another balance potentiometer, R8, is included so that resistor mismatches in the drive to the bootstrapping amplifier can be neutralized. Adding the bootstrapping amplifier also provides a connection point, as shown, for bias-current compensation if the ultimate in performance is required.

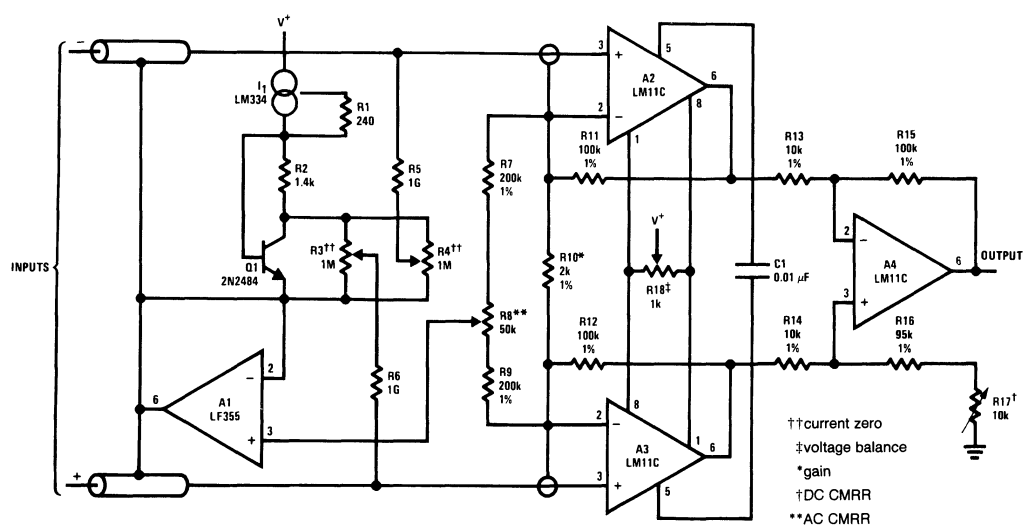


Figure 21. High gain differential instrumentation amplifier includes input guarding, cable bootstrapping and bias current compensation. Differential bandwidth is reduced by C1 which also makes common-mode rejection less dependent on matching of input amplifiers.

As can be seen in *Figure 22*, connecting the input amplifiers as followers simplifies the circuit considerably. But single resistor gain control is no longer available and maximum bandwidth is less with all the gain developed by A3. Resistor matching is more critical for a given common-mode rejection, but AC matching of the input amplifier is less a problem. Another method of trimming AC common-mode rejection is shown here.

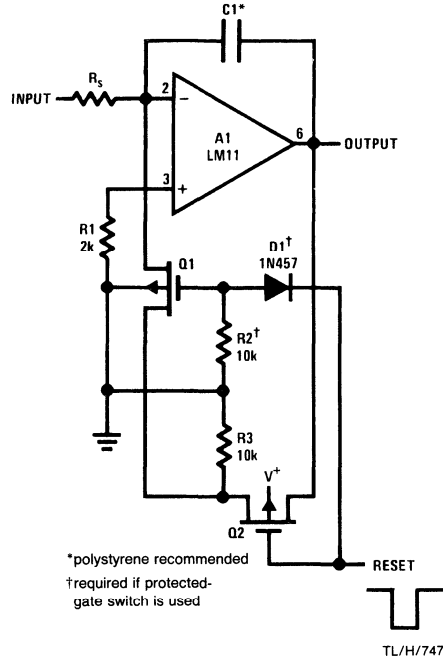
integrator reset

When pursuing the ultimate in performance with the LM11, it becomes evident that components other than the op amp can limit performance. This can be the case when semiconductor switches are used. Their leakage easily exceeds the bias current when elevated temperatures are involved.

The integrator with electrical reset in *Figure 23* gives a solution to this problem. Two switches in series are used to shunt the integrating capacitor. In the off state, one switch, Q2, disconnects the output while the other, Q1, isolates the leakage of the first. This leakage is absorbed by R3. Only the op amp offset appears across the junctions of Q1, so its leakage is reduced by two orders of magnitude.

A junction FET can be used for Q1 but not for Q2 because there is no equivalent to the enhancement mode MOSFET. The gate of a JFET must be reverse biased to turn it off and leakage on its output cannot be avoided.

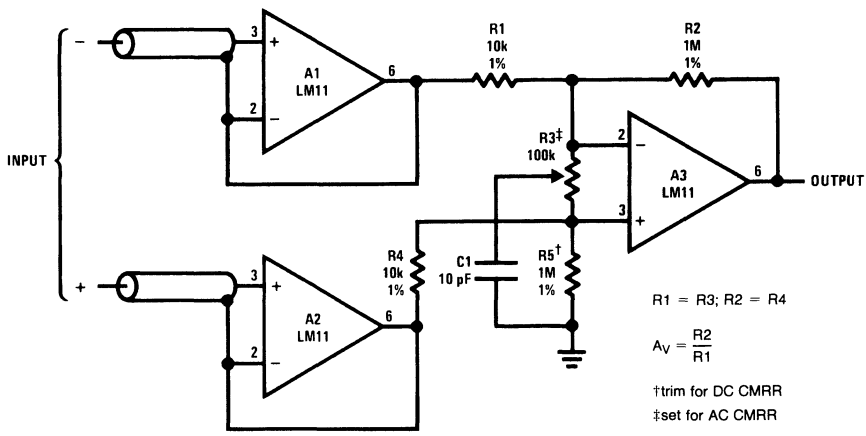
MOS switches with gate-protection diodes are preferred in production situations as they are less sensitive to damage from static charges in handling. If used, D1 and R2 should be included to remove bias from the internal protection diode when the switch is off.



*polystyrene recommended
†required if protected-gate switch is used

TL/H/7479-25

Figure 23. Reset is provided for this integrator and switch leakage is isolated from the summing junction. Greater precision can be provided if bias-current compensation is included.



R1 = R3; R2 = R4
 $A_v = \frac{R_2}{R_1}$
 †trim for DC CMRR
 ‡set for AC CMRR

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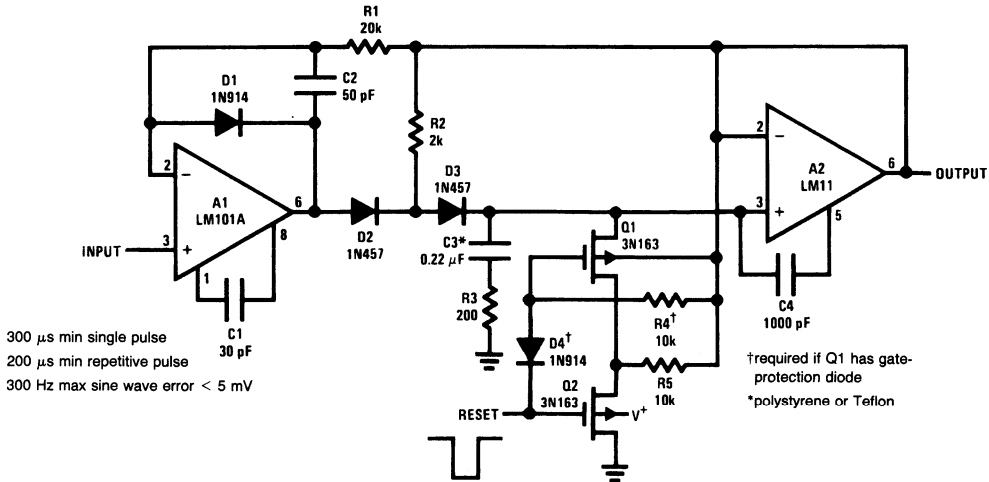
Figure 22. For moderate-gain instrumentation amplifiers, input amplifiers can be connected as followers. This simplifies circuitry, but A3 must also have low drift.

peak detector

The peak detector in *Figure 24* expands upon this idea. Isolation is used on both the peak-detecting diode and the reset switch. This particular circuit is designed for a long hold interval so acquisition is not quick. As might be expected from an examination of the figure, frequency compensation of an op amp peak detector is not exactly straightforward.

oven controller

The LM11 is quite useful with slow servo systems because impedance levels can be raised to where reasonable capacitor values can be used to effect loop stabilization without affecting accuracy. An example of this is shown in *Figure 25*. This is a true proportional controller for a crystal oven.

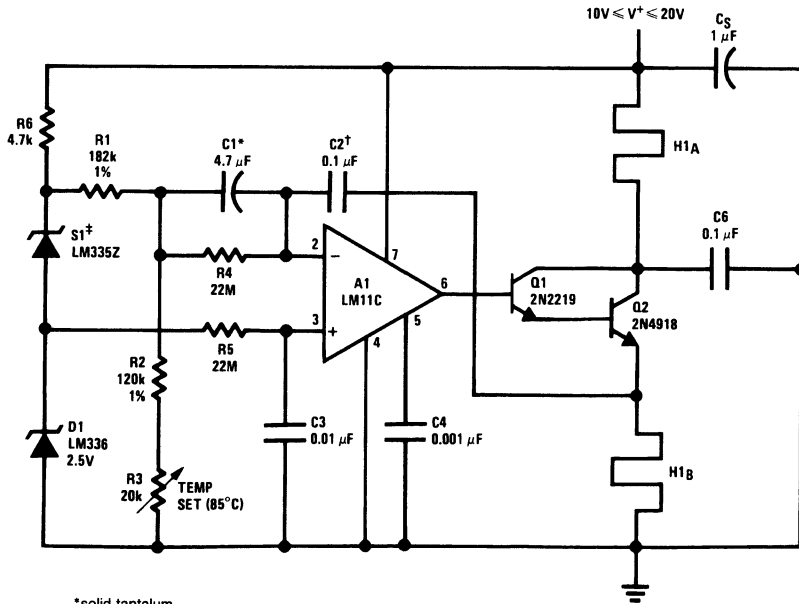


300 μs min single pulse
 200 μs min repetitive pulse
 300 Hz max sine wave error < 5 mV

†required if Q1 has gate-protection diode
 *polystyrene or Teflon

TL/H/7479-26

Figure 24. A peak detector designed for extended hold. Leakage currents of peak-detecting diodes and reset switch are absorbed before reaching storage capacitor.



*solid tantalum
 †mylar
 ‡close thermal coupling between sensor and oven shell is recommended.

TL/H/7479-27

FIGURE 25. Proportional control crystal oven heater uses lead/lag compensation for fast settling. Time constant is changed with R4 and compensating resistor R5. If Q2 is inside oven, a regulated supply is recommended for 0.1°C control.

Temperature sensing is done with a bridge, one leg of which is formed by an IC temperature sensor, S1, and a reference diode, D1. Frequency stabilization is done with C2 providing a lag that is finally broken out by C1. If the control transistor, Q2, is put inside the oven for maximum heating efficiency, some level of regulation is suggested for the heater supply when precise control is required. With Q2 in the oven, abrupt supply changes will alter heating, which must be compensated for by the loop. This takes time, causing a small temperature transient.

Because the input bias current of the LM11 does not increase with temperature, it can be installed inside the oven for best performance. In fact, when an oven is available in a piece of equipment, it would be a good idea to put all critical LM11s inside the oven if the temperature is less than 100°C.

ac amplifier

Figure 26 shows an op amp used as an AC amplifier. It is unusual in that DC bootstrapping is used to obtain high input resistance without requiring high-value resistors. In theory,

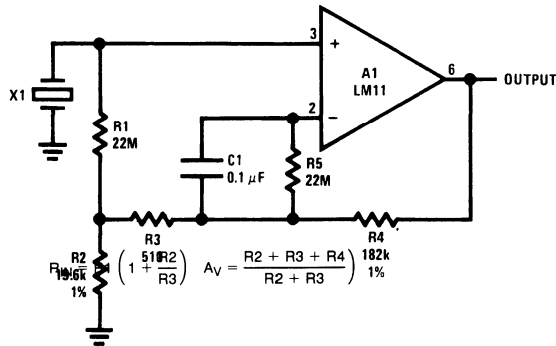
this increases the output offset because the op amp offset voltage is multiplied by the resistance boost.

But when conventional resistor values are used, it is practical to include R5 to eliminate bias-current error. This gives less output offset than if a single, large resistor were used. C1 is included to reduce noise.

standard cell buffer

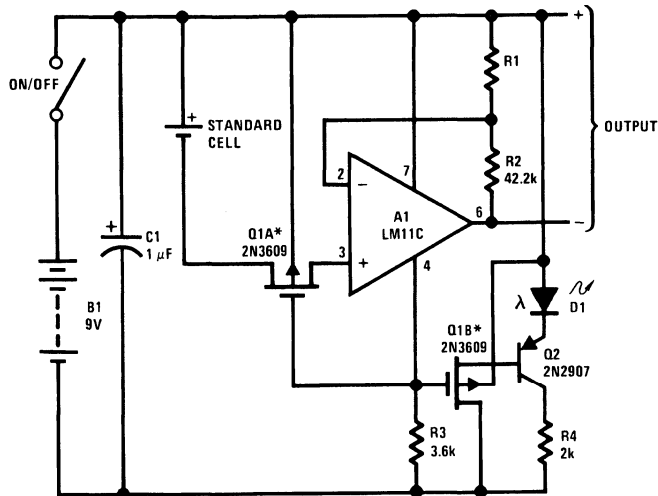
The accuracy and lifetime of a standard cell deteriorate with loading. Further, with even a moderate load transient, recovery is measured in minutes, hours or even days. The circuit in Figure 27 not only buffers the standard cell but also disconnects it in the event of malfunction.

The fault threshold is determined by the gate turn-on voltage of Q1. As the voltage on the gate approaches the threshold either because of low battery voltage or excessive output loading, the MOS switch will begin to turn off. At the turn off threshold, the output voltage can rise because of amplifier bias current flowing through the increasing switch resistance. Therefore, a LED indicator is included that extin-



TL/H/7479-28

Figure 26. A high input impedance AC amplifier for a piezoelectric transducer. Input resistance of 880 MΩ and gain of 10 is obtained.



TL/H/7479-29

*cannot have gate protection diode; $V_{TH} > V_{OUT}$

Figure 27. Battery powered buffer amplifier for standard cell has negligible loading and disconnects cell for low supply voltage or overload on output. Indicator diode extinguishes as disconnect circuitry is activated.

guishes as the fault condition is approached. The MOS threshold should be higher than the buffer output so that he disconnect and error indicator operates before the output saturates.

conclusions

Although the LM11 does not provide the ultimate in performance in either offset voltage or bias current for nominal room temperature applications, the combination offered is truly noteworthy. With significant temperature excursions, the results presented here are much more impressive. With full-temperature-range operation, this device does represent the state of the art when high-impedance circuitry is involved.

Combining this new amplifier with fast op amps to obtain the best features of both is also interesting, particularly since the composite works well in both the inverting and non-inverting modes. However, making high-impedance circuits fast is no simple task. If higher temperatures are not involved, using the LM11 to reduce the offset voltage of a FET op amp without significantly increasing bias current may be all that is required.

An assortment of measurement and computational circuits making use of the unique capabilities of this IC were presented. These circuits have been checked out and the results should be of some value to those working with high impedances. These applications are by no means all-inclusive, but they do show that an amplifier with low input current can be used in a wide variety of circuits.

Although emphasis was on high-performance circuits requiring adjustments, the LM11 will see widest usage in less demanding applications where its low initial offset voltage and bias current can eliminate adjustments.

acknowledgement

The authors would like to thank Dick Wong for his assistance in building and checking out the applications described here.

*** See Addendum(TP-15) that follows
this Application Note.**

Reducing DC Errors in Op Amps

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Addendum to AN-241/AN-242
(formerly TP-15)



Abstract. An IC op amp design that reduces bias currents below 100 pA over a -55°C to $+125^{\circ}\text{C}$ temperature range is discussed. Super-gain bipolar transistors with on-wafer trimming are used, providing low offset voltage and drift. The key to low bias current is the control of high temperature leakage currents along with the development of reasonably accurate nanoampere current sources with low parasitic capacitance.

Introduction

A bipolar replacement for the LM108 [1] drastically reduces offset voltage, bias current and temperature drift. This design, the LM11, does not depend on new technology. Instead, the improvements result from a better understanding of transistor behavior, new circuit techniques and the application of proven offset trimming methods. Table I summarizes the results obtained. The combination of low offset voltage and low bias current is unique to IC op amps, while the performance at elevated temperatures represents an advance in the state of the art.

TABLE I. Input error terms of the LM11 show an improvement over FET op amps even at room temperature. There is little degradation in performance from -55°C to 125°C . Other important specifications are somewhat better than LM108A.

Parameter	$T_j = 25^{\circ}\text{C}$		$-55^{\circ}\text{C} \leq T_j \leq +125^{\circ}\text{C}$	Units
	Typ	Max	Max	
Input Offset Voltage	0.1	0.3	0.6	mV
Input Offset Current	0.5	10	30	pA
Input Bias Current	25	50	150	pA
Offset Voltage Drift	1		3	$\mu\text{V}/^{\circ}\text{C}$
Offset Current Drift	20			$\text{fA}/^{\circ}\text{C}$
Bias Current Drift	0.5		0.5	$\text{pA}/^{\circ}\text{C}$

Junction FETs

At first glance, field effect transistors seem to be the ideal input stage for an op amp, mainly because they have a low gate current, independent of their operating current. Practically, they do provide an attractive combination of performance characteristics in a relatively simple design. But there are serious shortcomings.

For one, FETs do not match as well as bipolar devices: the offset voltage is at least an order of magnitude worse. Laser trimming can compensate for this to some extent. But with FETs, low offset voltage does not guarantee low drift, as it

does with bipolars. FETs are also sensitive to mechanical strains and subject to offset shifts during assembly or with temperature cycling.

Typically, long term stability is about $100 \mu\text{V}/\text{year}$, although this can go to $1 \text{ mV}/\text{year}$ with no prior warning in early life. This contrasts to a $10 \mu\text{V}/\text{year}$ long term stability for bipolar pairs.

Lastly, although the input current of FETs is low at room temperature, it doubles for every 10°C increase. This, coupled with high offset voltage drift, makes FETs much less attractive as operating temperature is increased.

MOS FETs

Field effect transistors, with a metal gate and oxide insulation, give the ultimate in low input current. Practically, this advantage disappears when diodes are included to protect the gate from static charges encountered in normal handling. Further, the offset voltage problems of JFETs go double for MOS FETs. They are also subject to offset shifts due to contamination.

Interesting designs are on the horizon for various chopper-stabilized complementary MOS ICs. These solve most offset voltage problems, but not that of input leakage current. Even at moderate temperatures, this input current will seriously degrade the low offset voltage and drift even with relatively low source resistances. Chopper-stabilized amplifiers have added problems with overload recovery and noise, especially with high source impedances. These problems have limited solutions, but chopper stabilization is not usually suitable for general purpose applications.

bipolar op amps

Offset voltage, its drift or long term stability has not been a serious problem with bipolar-input op amps. Such techniques as cross-coupling or zener-zap trimming have reduced offset voltage to $25 \mu\text{V}$ in production. The real problem has been bias current. The LM108, introduced in 1968, has represented the state of the art in low bias currents for standard bipolar devices. At 3 nA , maximum over temperature, the bias current is lower than FETs above 85°C .

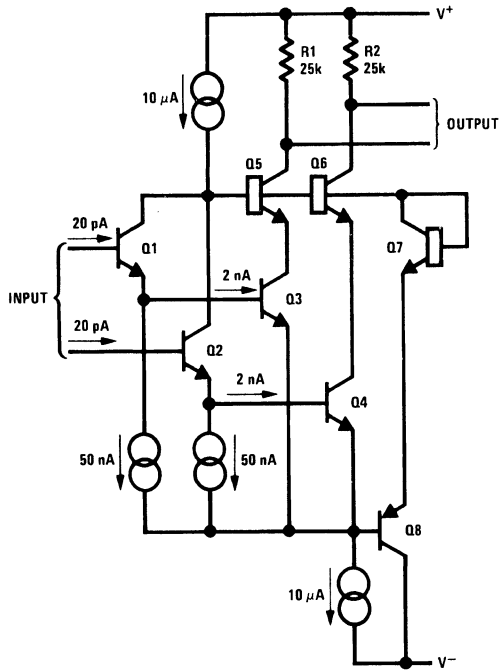
A Darlington version of the LM108, the LM216, provided bias currents in the 50 pA range; but this design was seriously marred by high offset voltage, drift, excessive low frequency noise and anomalous leakage currents at higher temperatures.

Improvements in this design were thwarted by the inability to provide nanoampere bleed currents to stabilize the Darlington input and the erroneous belief that uncontrollable surface states created the anomalous leakage.

a new design

With bipolar transistors, there is a tradeoff between current gain and breakdown voltage. Super-gain transistors are devices that have been diffused for maximum current gain at the expense of breakdown voltage (which is typically a couple volts for a current gain of 5000). These low voltage transistors can be operated in a cascode connection with standard transistors to give a composite device with both high gain and breakdown voltage.

Figure 1 shows a modified Darlington input stage for a super-gain op amp. Common base standard transistors (Q5 and Q6, drawn with a wider base) are bootstrapped to the super-gain input transistors so that the latter are operated at near zero collector base voltage. In addition to permitting the use of super-gain inputs, this connection also isolates the input transistors from common-mode variations, increasing common-mode rejection.



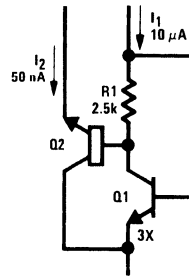
TL/H/8722-1

Figure 1. Bootstrapped input stage using super-gain transistors in modified-Darlington connection. The objectionable characteristics of the Darlington are virtually eliminated by operating the input transistors at a much larger current than the base current of the transistors they are driving.

The usual problems with the Darlington connection are avoided by providing a bleed current that operates the input transistors, Q1 and Q2, at a current much higher than the base current of the transistors they are driving, Q3 and Q4. This is necessary because the base currents are not that well matched, especially over temperature, and have excess low frequency noise.

a nanoampere current source

A circuit that generates the 50 nA bleed current is shown in Figure 2. A super-gain transistor operated in the forward mode is used to bias a standard transistor in the reverse mode. The reverse connection is used because the capacitance of an ordinary collector tub would reduce the common-mode slew rate from 2 V/μs to 0.02 V/μs.



$$I_2 = \frac{h_{fe2}A_2I_1}{h_{fe1}A_1} \exp \frac{qV_{BE}R_1}{kT}$$

TL/H/8722-2

Figure 2. Forming a nanoampere current source with low parasitic capacitance. Design takes advantage of predictable V_{BE} difference between standard and super-gain transistors and fact that V_{BE} of a transistor is the same when operated in forward or reverse mode.

At first look, this biasing scheme would seem to be subject to a number of process variations. This is not so. For one, the V_{BE} of a transistor depends on the base Gummel number (Q_B/μ_B), the number of majority carriers per unit area divided by their effective mobility. Since the Gummel number and the effective area are unchanged when the collector and emitter are interchanged, the V_{BE} will be the same in either connection, provided that base recombination is not excessive. In standard IC transistors, reverse h_{FE} is about 30, indicating that recombination is not a significant factor. Measured reverse h_{FE} is much lower, but this is the result of a parasitic PNP that does not affect V_{BE} or α_E, the common base current gain.

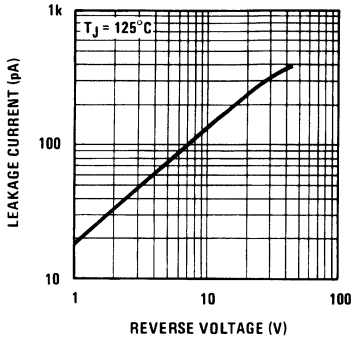
The bleed current depends also on the ratio of super-gain to standard transistor h_{FE}, as indicated by the equation in Figure 2. Intuition suggests that super-gain h_{FE} will increase much faster than standard transistor h_{FE} with increasing emitter diffusion time, giving lower bleed current with higher super-gain h_{FE}. However, measurements with variances of standard LM108 processing indicate that the bleed current remains within 25% of design center.

As shown in Figure 2, higher current ratios can be obtained by increasing the area of Q1 relative to Q2 or by including R1. The equation in Figure 2 assumes that I₁ varies as absolute temperature. If the voltage drop across R1 is equal to kT/q, changes in the V_{BE} of Q1 with small changes in I₁ will be cancelled by changes in the voltage drop across R1. This makes input bias current essentially unaffected by variations in supply or common-mode voltage as long as I₁ is reasonably well controlled.

leakage currents

The input leakage currents of bipolar op amps can be kept under control because small geometry devices are satisfactory and because the collector-base junction can be operated at an arbitrarily low voltage if bootstrapping is used.

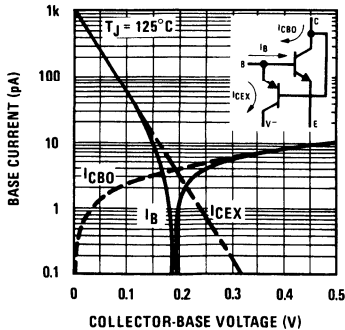
Simple theory predicts that bulk leakage saturates for reverse biases above $2kT/q$. But generation in the depletion zone dominates below 125°C . Because the depletion width varies with reverse bias, so does leakage. The characteristics of a high quality junction plotted in *Figure 3* show that leakage current can be reduced with lower bias.



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Figure 3. Voltage sensitivity of collector base leakage indicates that generation in the depletion zone dominates even at 125°C .

When more than one junction is involved, minimum leakage is not necessarily obtained for zero bias. This is illustrated in *Figure 4*, a plot of I_{CBO} for a junction isolated NPN transistor. A parasitic PNP is formed between the base and the isolation as diagrammed in the inset. Zero leakage is obtained when V_{CB} is set so that the PNP diffusion current equals I_{CBO} of the NPN.



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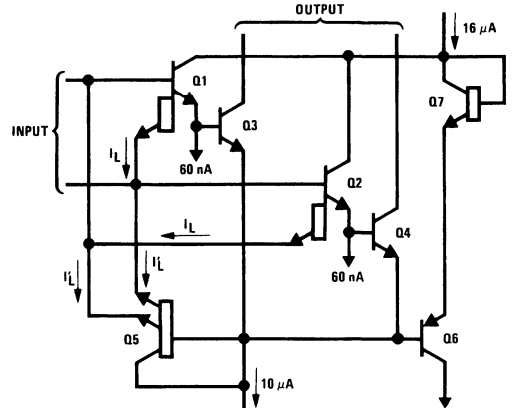
Figure 4. Plot above explains "anomalous" leakage of NPN transistors in ICs. As collector base bias is reduced, base current reverses then increases exponentially. This excess current is the forward diffusion current of parasitic PNP to substrate (see inset).

input protection

The input clamps perform a dual function. Most important, they protect the emitter base junction of the input transistors from damage by in-circuit overloads or static charges in handling. Secondly, they limit the voltage change across

junction capacitances on low current nodes under transient conditions. This minimizes recovery delays.

The clamp circuitry is shown in *Figure 5*. Emitters are added on the input transistors and cross-coupled to limit the differential input voltage. Another transistor, Q5, has been added to limit voltage on the input transistors if the inputs are driven below V^- .



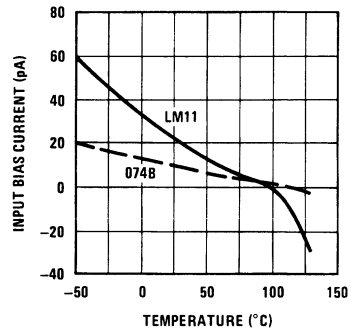
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Figure 5. Separate clamps are used for differential and common-mode overloads. Leakage currents, I_{CES} of forward and reverse connected transistors, cancel.

The differential clamp transistors do contribute to input current because $V_{CB} > 0$, so collector current is not zero for $V_{BE} \approx 0$ ($I_{CES} \approx 100 \text{ pA}$ at 125°C). The common-mode input clamp, Q5, is also operated at $V_{BE} = 0$ and $V_{CB} > 0$, although in the inverted mode. The resulting error is diffusion current, dependent only on the characteristic V_{BE} of the transistors. Thus, the current contributed by the differential clamp transistors is cancelled, within a couple percent, by that from the common-mode clamp.

bias current

Figure 6 shows some results of the design approach described here. A room temperature bias current of 25 pA is obtained, and this is held to 60 pA over a -55°C to 125°C temperature range. The figure also shows the results of

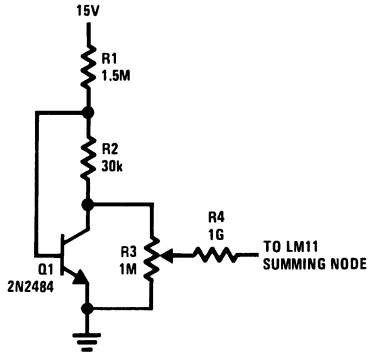


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Figure 6. Input bias current of the LM11 remains low over military temperature range. Improvements in development give even better results (074B). Offset current is usually below 1 pA.

some improvements in development that have reduced bias current to 20 pA over the full operating temperature range.

Figure 6 shows that bias current is very nearly a linear function of temperature, at least from -55°C to +100°C. This, coupled with the fact that bias current is virtually unaffected by changes in common-mode or supply voltage, suggests that bias current compensation can be provided for critical applications. An appropriate circuit is shown in Figure 7. Details are given in reference [2], but properly set up it should be possible to hold bias currents to less than 20 pA over a -55°C to +100°C temperature range or 5 pA over a 15°C to 55°C range with a simple room temperature adjustment.



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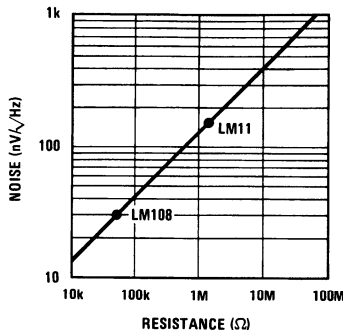
Figure 7. Bias current of LM11 varies linearly with temperature so it can be effectively compensated with this circuit. Bias currents less than 5 pA over 15°C to 55°C range or 20 pA over -55°C to +100°C are practical.

noise

The broadband noise of a bipolar transistor is given by

$$e_n = kT\sqrt{2\Delta f/qI_c} \quad (1)$$

Therefore, operating the input transistors at low collector current does increase noise. Because the noise of most op amps is greater than the theoretical noise voltage of the input transistors, the noise increase from low current input buffers is not as great as might be expected. In addition,

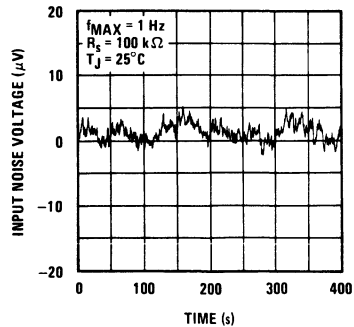


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Figure 8. Increased noise of LM11 is consequence of low collector current in input transistors. But in high impedance applications, op amp noise is masked by the thermal noise of source resistance given above.

when operating from higher source resistances, op amp noise is obscured by resistor noise, as shown in Figure 8.

Low frequency noise is not as easily accounted for as broadband noise, but lower operating currents increase noise in much the same fashion. The low frequency noise of the LM11, shown in Figure 9, is a bit less than FETs but greater than that of the LM108 when it is operated from source resistances less than 500 kΩ.



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Figure 9. Low frequency noise of LM11 is high compared to other bipolar devices but somewhat less than FETs. It is equal to LM108 operating from 500 kΩ source resistances.

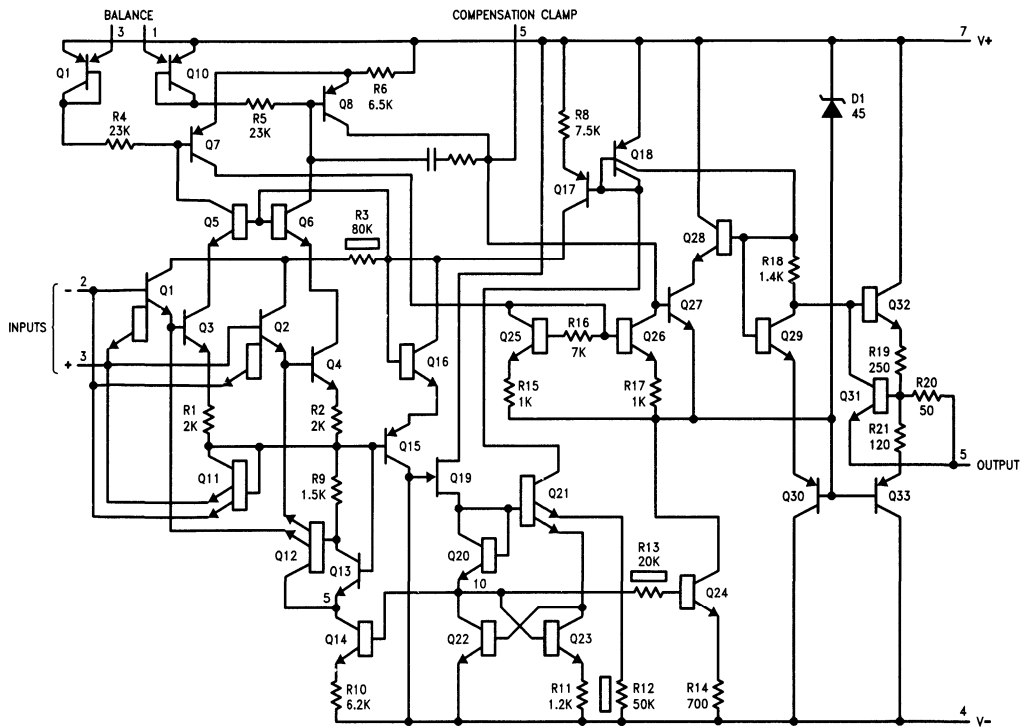
complete circuit

A schematic diagram of an IC op amp using the techniques described is shown in Figure 10. Other than the input stage, the circuitry is much like the LM112, a compensated version of the LM108 that includes offset balancing.

One significant change has been the inclusion of wafer level trimming for offset voltage. This is done using zener-zap trimming across portions of the input stage collector load resistors, R4 and R5. This kind of zener is simply the emitter base junction of an NPN transistor. When pulsed with a large reverse current at wafer sort, the junction is destroyed by the formation of a low resistance filament between the emitter and base contact beneath the protective oxide. This shorts out a portion of the collector load resistor. The process is repeated on binary weighted segments until the offset voltage has been minimized.

Offset voltage of the LM11 is conservatively specified at 300 μV. Although low enough for most applications, offset voltage trimming is provided for fine adjustment. Balance range is determined by the resistance of the balance potentiometer, varying from ±5 mV at 100 kΩ to ±400 μV at 1 kΩ. Incidentally, when nulling offset voltages of 300 μV, the thermal matching of balance-pot resistance to the internal resistors is not a significant factor.

The actual balancing is done on the emitters of lateral PNP transistors, Q9 and Q10, that imbalance the collector loads of the input stage. This particular arrangement was used so that no damage would result from accidental connection of the balance pins to voltages outside either supply. Not obvious is that a balance pin voltage 15V more negative than V⁺ can effectively short these PNP transistors with a parallel P-channel MOS transistor, forcing the output to one limit or another.



TL/H/8722-10

Figure 10. Complete schematic of the LM11. Except for the input stage, circuit is much like the LM112, a compensated version of the LM108 that includes offset balancing.

Although the LM11 is specified to a lower voltage than the LM108, the minimum common-mode voltage is a diode drop further from V^- because the bleed current generator, Q12 and Q13, has been added.

Proceeding from the input stage, the second stage amplifier is a differential pair of lateral PNPs, Q7 and Q8. These feed a current mirror, Q25 and Q26, which drive a super-gain follower, Q27. The collector base voltage of Q26 is kept near zero by including Q28. The current mirror is bootstrapped to the output so that second stage gain error depends only on how well Q7 and Q8 match with changes in output voltage. This gives a gain of 120 dB in a two stage amplifier. Frequency compensation is provided by MOS capacitor C1.

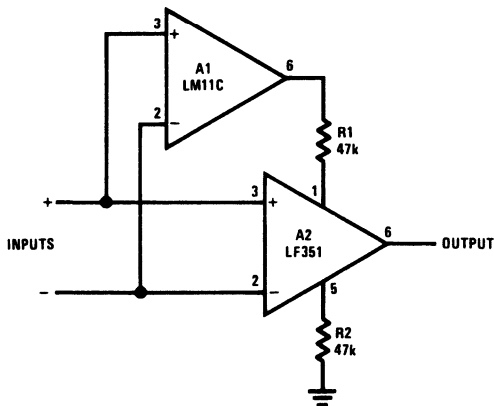
The output stage is a complementary class-B design with current limiting. Biasing has been altered so that the guaranteed output current is twice the LM108. A zener diode, D1, limits output voltage swing to prevent stressing the MOS capacitor to the point of catastrophic failure in the event of gross supply transients.

The main bias current generator design (Q20-Q23) is due to Dobkin [3]. It is powered by Q19, a collector FET. The circuit is auto-compensated so that output current of Q14 and Q21 varies as absolute temperature and changes by less than 1% for a 100:1 shift in Q19 current.

speed

With a unity gain bandwidth of 500 kHz and a $0.3 \text{ V}/\mu\text{s}$ slew rate the LM11 is not fast. But it is no slower than might be expected for a supply current of only $300 \mu\text{A}$.

If the precision of the LM11 is required along with greater speed, the circuit in *Figure 11* might be used. Here, the LM11 senses input voltage and makes appropriate adjustments to the balance terminals of a fast FET amplifier. The main signal path is through the fast amplifier.



TL/H/8722-11

Figure 11. The LM11 can zero offset of fast FET op amp in either inverting or non-inverting configurations. Speed is that of fast amplifier. FET amplifier can be capacitively coupled to critical input to eliminate its leakage current.

Surprisingly, this connection will work even as a voltage follower. The common-mode slew recovery of the LM11 is about $10 \mu\text{s}$ to 1 mV , even for 30V excursions. This was accomplished by minimizing or bootstrapping stray capacitances and providing clamping to limit the voltage excursion across the strays.

When bias current is an important consideration, it will be advisable to ac couple the FET op amp to the critical input. Reference [2] discusses this and other practical aspects of fast operation with the LM11.

conclusions

A new IC op amp has been described that can not only increase the performance of existing equipment but also creates new design possibilities. Op amp error has been reduced to the point where other problems can dominate. Many of the practical difficulties encountered in high impedance circuitry are discussed in reference [4] along with solutions. A number of tested designs using these techniques are given in reference [2].

The LM11 is not the result of any breakthrough in processing technology. It is simply a modification of ICs that have been in volume production for over 10 years. The improvements have resulted primarily from an understanding of strange behavior observed on the earlier ICs and taking advantage of certain inherent characteristics of bipolar transistors that were not fully appreciated.

As users of the LM11 may have discovered, the offset voltage and bias current specifications are quite conservative. It seems possible to offer $50 \mu\text{V}$ offset voltage and perhaps $1 \mu\text{V}/^\circ\text{C}$ drift even on low cost parts. Taking full advantage of 5 pA bias current would require guarded 10-pin TO-5 packages or 14-pin DIP packages. Further, the feasibility of reducing low frequency noise to $2 \mu\text{V}$ and 0.1 pA , peak to peak, has been demonstrated on prototype parts.

acknowledgement

The author would like to acknowledge the contributions of Dennis Foltz for solving the rather formidable production test problems of the LM11.

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- [2] R.J. Widlar, R. Pease and M. Yamatake, "Applying a new precision op amp", National Semiconductor AN-242, April 1980.
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Introduction to Practical Fiber Optics

National Semiconductor
Application Note 244
Eric Miller



INTRODUCTION

We have all heard a great deal about fiber optics in the past number of years. Unfortunately, most of the discussion is about very high performance communications links. 200 Mbit, 20 Kilometer repeater-less links, jeweled connectors, solid state cooled lasers for transmission, and avalanche photodiodes for reception seem to be the rule. There is another side to fiber optics which is usually neglected, and that is the under-a-kilometer, less-than-50-Mbit fiber optic links. It is the purpose of this application note to de-mystify fiber optics in general, and to bring it into the designer's arsenal of problem-solving tools. We will primarily discuss fiber optic communications from a digital standpoint, but touch on a few analog applications. Fiber optic cable and connectors will be presented, followed by output transducers and transmitter circuitry, and finally input transducers and receiver circuitry.

First, however, we should review the fundamental advantages that fiber optics can bring. Superb electrical isolation can be obtained which also eliminates many grounding and safety-related problems. Fiber optic cable at this time is cost competitive with coax, and prices will drop dramatically as volume increases due to improved production techniques and abundant raw material (sand), its small size, light weight, and ruggedness surpass copper wire in every respect. Compared to coaxial cable, fiber optic cable significantly reduces signal attenuation while providing a much wider bandwidth. Crosstalk between adjacent pairs of optical fibers is eliminated by simply inserting each fiber in an opaque sheath. Fiber optic cable is EMI and RFI immune; neither is it susceptible to nor does it emit electromagnetic radiation.

Figure 1 shows a simplified diagram of a fiber optic link. An analog or digital input is conditioned by the transmitter circuitry and drives either an LED or semiconductor laser diode. This modulated light is launched into a fiber optic cable, terminated with the desired connectors on both ends. At the receiving end, a PIN photodiode or avalanche photodiode converts the incident light to a low level current which is processed by the receiver circuitry to provide a useful analog or digital output. Full duplex operation would require two such links.

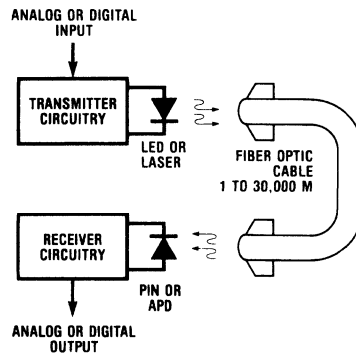
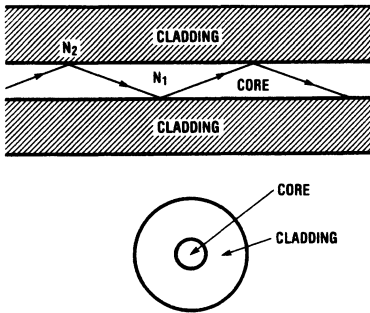


FIGURE 1

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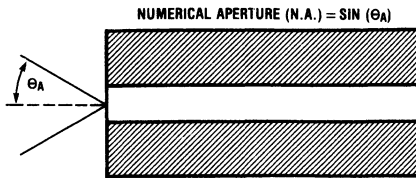
FIBER OPTIC CABLE

An end view and a cutaway view of a single stepped index optical fiber is shown in *Figure 2*. A stepped index fiber refers to the abrupt change in the index of refraction between the core and the cladding. All transmission of light occurs within the core. Given a core index of refraction n_1 and a cladding index of refraction n_2 , there will be a critical angle such that any light ray entering the core at less than that critical angle will be totally reflected. It is in this manner that light will propagate down the length of the optical fiber. This mechanism also gives rise to the term numerical aperture. The numerical aperture is defined as the Sine of the aforementioned critical angle, as shown in *Figure 3*. The numerical aperture defines a cone in which incident light may be launched into the cable, and in which light will emerge from the cable. The smaller the given numerical aperture, the more difficult it is to launch light into the fiber.



TL/H/8748-2

FIGURE 2. Stepped Index Fiber Cross Section

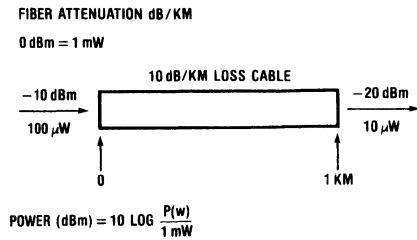


TL/H/8748-3

FIGURE 3. Numerical Aperture

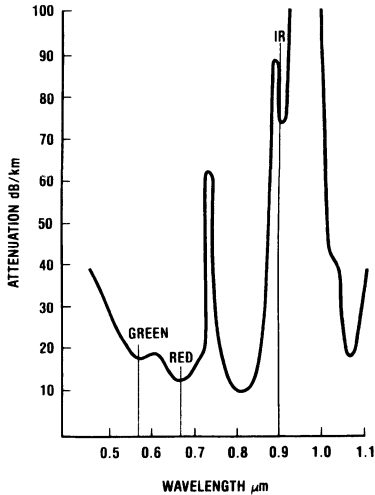
Fiber Attenuation

The most important fiber specification is usually its attenuation characteristics. Specified at a given wavelength, the attenuation is measured in decibels per kilometer. Optical fibers are available whose attenuation can range from 0.2 dB/km to 10,000 dB/km. *Figure 4* shows a simple example. We will suppose that we have an optical fiber whose attenuation at the wavelength of interest is 10 dB/km. Light levels are measured in terms of power, and often expressed as dBm, i.e., referenced to 1 mW. Therefore, if we launch 100 μ W of light into the cable (-10 dBm) and the cable is 1 km long, the light power at the receiving end will be 10 μ W or -20 dBm. As previously mentioned, we must know the wavelength at which we are going to operate. Most red LED's emit light at 660 nM, yellow at 585 nM, green at 565 nM and infrared (IR) at 900 nM. *Figure 5* shows a typical fiber's attenuation versus wavelength characteristics. Note that the attenuation can vary widely depending upon the chosen wavelength. A green LED would be attenuated by 18 dB/km, a red LED 11 dB/km. An IR LED would be significantly attenuated by 90 dB/km. *Figure 6* shows a somewhat better behaved wavelength-attenuation graph. This happens to be for a graded index fiber. Graded index refers to the index of refraction gradually decreasing as the distance away from the center of the cable. Note that there is no single wavelength that is optimum for all fibers. Careful consideration must be given to selecting the appropriate cable for use with the chosen emitter wavelength.



TL/H/8748-4

FIGURE 4. Fiber Attenuation (dB/km)



TL/H/8748-5

FIGURE 5. Typical Fiber Attenuation versus Wavelength (Step Index)

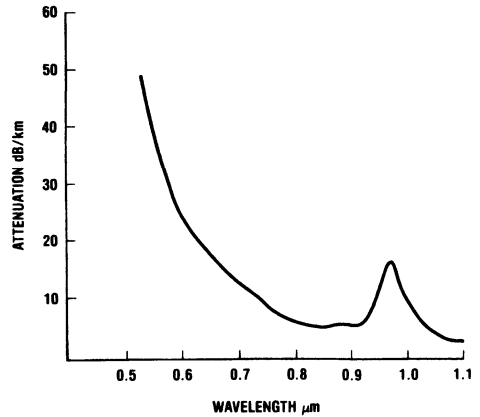
Numerical Aperture

Each fiber has a characteristic numerical aperture which is usually between 0.2 and 0.4. This corresponds to light entry half angles of 11 to 24 degrees respectively. Large bandwidth low attenuation cables typically exhibit smaller numerical apertures. The core index of refraction is usually given in a data sheet; we can then calculate the propagation delay down a given length of cable. The propagation speed is simply the speed of light divided by the core index of refraction. For example, if a fiber's core index of refraction is 1.5, then the speed at which light will travel down the fiber is 2×10^8 meters per second. Thus it will take 500 ns for light to travel to the end of a 100 meter cable.

Bandwidth

We also need to know the bandwidth of the cable chosen. This specification may be given as MHz/km or as a more obtuse spec; -3 dB intermodal dispersal expressed in ns/km. A 200 MHz/km cable will exhibit an attenuation of -3 dB at 200 MHz at the end of a 1-km long cable. To calculate the bandwidth constraint from the intermodal dispersion expressed in ns/km, simply divide 0.35 by the given specification. Thus, if a fiber is characterized by a 3 ns/km - 3 dB intermodal dispersion, this is equivalent to 116 MHz/km. In simpler terms, when the dispersion is given in ns/km, this indicates the increase in signal rise time per a given length of fiber.

Fiber core diameter can vary from less than 10 μM to more than 1500 μM . In general, high bandwidth, low attenuation fibers are available in small diameter fiber cores and small numerical apertures. *Figure 7* gives a list of a few cable and fiber manufacturers. Cables are available with one fiber per cable to upwards of twenty.



TL/H/8748-6

FIGURE 6. Typical Fiber Attenuation versus Wavelength (Graded Index)

EXAMPLES OF CABLE AND FIBER MANUFACTURERS

BELDEN
CANSTAR
CORNING
DUPONT
GALILEO
ITT
OPTELCOM
QUARTZ PRODUCTS
SIECOR
TIMES WIRE AND CABLE
VALTEC

FIGURE 7. Cable and Fiber Manufacturers

Connectors

Although there is no standard cable connector, the AMP and SMA type connectors are the most popular. *Figure 8* gives a representative list of connector manufacturers. In general, inexpensive plastic type connectors are capable of less than 3 dB of insertion loss on fibers as small as 125 μM . Smaller fibers, or lower insertion loss, require the use of metal connectors at increased cost. Connectors are available in single or multiple fiber versions, and one can obtain connectors where the user may mix conventional wire conductors with optical fibers in the same connector.

PARTIAL LIST OF CONNECTOR MANUFACTURERS

AMP
 AMPHENOL
 AUGAT
 BELDEN
 BENDIX
 DEUTCH
 ITT CANNON
 3M
 PLESSEY
 THOMAS & BETTS
 TRW

FIGURE 8. Connector Manufacturers

OPTICAL EMITTERS

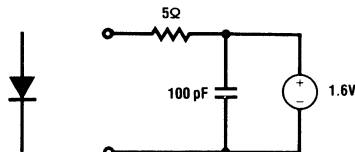
The two most practical methods of converting electrical signals to light for fiber optics are via the light emitting diode or laser diode. Typical LED's used as panel lights can produce 15 to 30 μ W of optical power. LED's that are designed for fiber optic use can produce up to 10 mW. An electrical equivalent circuit for a typical LED is shown in *Figure 9*. Typical operating currents are in the range of 50 to 100 mA peak with a forward voltage of 1.6 to 2.0V.

Light Emitting Diodes

LED's are normally broken down into three categories, surface, edge and Burrus. Surface emitters emit light over the entire surface of the die whereas edge emitters produce maximum light power along the edge of the die. The Burrus LED emits light from an etched well in the surface of the LED; this permits tailoring the size of the well to the diameter of the optical fiber being used.

Speed of response can vary from a few ns to 500 ns. Note that even if we are able to impress the proper voltage across an LED, and the proper current through it, this does not mean that we have optical power output. Consult the manufacturer or the data sheet to ascertain if the chosen LED will support the bandwidth or data rate for which the link is designed.

LED's are obtainable with wavelengths from green (565 nm) to infrared (1300 nm). Conventional red (660 nm) is the most popular and the least expensive. *Figure 9* also lists a number of manufacturers of LED's and laser diodes.



LED and Equivalent Circuit

TL/H/8748-7

REPRESENTATIVE MANUFACTURERS OF EMITTERS—
LASER AND LED

ABORN
 FAIRCHILD
 GENERAL OPTRONICS
 HP
 ITT
 LASER DIODE LABS
 MATH ASSOCIATES
 MERET
 MONSANTO
 MOTOROLA
 NATIONAL SEMICONDUCTOR
 PLESSEY
 RCA
 SPECTRONIC
 TI

FIGURE 9. Emitters—Laser and LED Manufacturers

Laser Diodes

There are two popular kinds of laser diodes, single and double heterostructure. The single heterostructure laser diode is not capable of producing continuous optical power. It must be used in a small duty cycle mode with typical pulse widths of 100 ns. Output power is high (10W), although the drive requirements are severe, 6 to 30A peak. The double heterostructure laser diode is similar to an LED in ease of use. It exhibits no duty cycle limitations, and requires about 100 to 400 mA peak current for typical operation. Output power is 10–20 mW, wavelength is near 900 nm, and optical rise-time is less than a nanosecond. Unfortunately, the price of these lasers at the time of this writing is still high, approximately \$1000 each, although the price is expected to drop dramatically over the next few years.

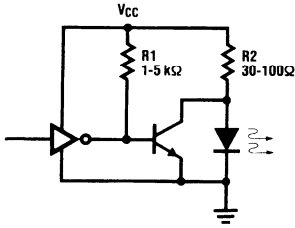
TRANSMITTER CIRCUITRY

Figure 10 shows three methods of modulating LED's. In *Figure 10a*, an open collector TTL gate drives a transistor which shunts current away from the LED in the off state. When the input to the gate is low, the transistor is turned off and resistor R2 supplies the desired on current. This method is good for data rates to 20 megabits.

Figures 10b and *10c* show how to modulate an LED linearly. U1 is any general purpose op amp and operates as a voltage controlled current source with the LED as the load. Q1 is a general purpose NPN (2N2222), which is capable of supplying up to 100 mA necessary for driving the LED. Note that the circuit works for positive input voltages only. High speed operation may be obtained by using wide bandwidth

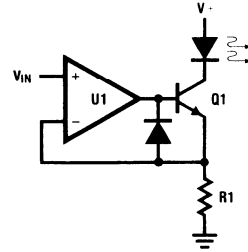
op amps such as the LH0032. *Figure 10c* illustrates an alternative method of analog modulation. An LH0002 unity gain buffer is used, with the LED in the positive supply of the buffer. An input voltage is converted to a drive current for the LED by means of driving load resistor R1. The 6 to 10 mA of LH0002 quiescent supply current also flows thru the LED. A shunt resistor in parallel with the LED can divert the bulk of this current, if desired.

The transmitter circuitry remains fairly simple for data rates to 50 Mbps. Temperature compensation of optical output power can be easily accomplished if necessary with the addition of a small amount of circuitry as shown in *Figure 10d*.



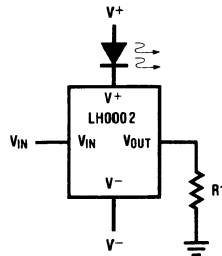
TL/H/8748-8

FIGURE 10a. Digital Transmitter



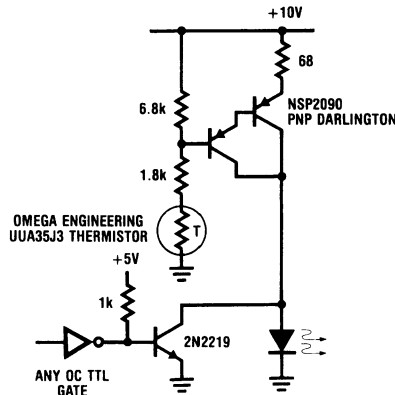
TL/H/8748-9

FIGURE 10b. Analog Transmitter



TL/H/8748-10

FIGURE 10c. Fast Analog Transmitter

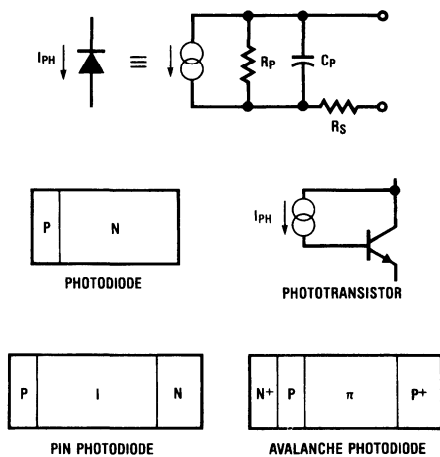


TL/H/8748-11

FIGURE 10d. Temperature Compensation

OPTICAL SENSORS

The receiver circuitry for fiber optic transmission is slightly more difficult. First, we will discuss the basic characteristics of the most commonly used photodetectors. The four most popular photosensors are shown in *Figure 11*. The photodiode, phototransistor, PIN photodiode and avalanche photodiode all operate on the same basic principle. An incident photon creates a hole-electron pair near or within the depletion region. The electrical field separates the pair and causes current to flow in an external circuit. *Figure 11* also shows an equivalent circuit for photodiode. R_S is usually on the order of 10 to 100 Ω , R_P is 10⁹ to 10¹⁰ Ω typically, and C_P is the photodiode's capacitance, dependent upon processing and area. Note the direction of photo-induced current flow, as conventional current is sourced by the anode. This is not the same mode typically used for solar cell operation—the photovoltaic mode. In this mode, a portion of the photocurrent flows thru the photodiode itself, producing a voltage from anode to cathode. The photocurrent mode, however, is superior to the photovoltaic mode in linearity, speed of response, stability and temperature coefficient. Thus, we will limit our circuitry discussion to using the photodiode in the photocurrent mode alone.



TL/H/8748-12

FIGURE 11. Photodetectors

Phototransistor

The phototransistor can be modeled by a photo-induced current source between the collector and the base. Beta multiplication produces a much larger photocurrent at the emitter or collector; however, this is at the expense of speed of response. The small photocurrent must charge the base-emitter capacitance, producing slow rise and fall times. Gain-bandwidth is typically 200 MHz. The uncertainty in sensitivity due to beta variations, and the slow response relegate the phototransistor to relatively low performance fiber optic receivers.

PIN Photodiode

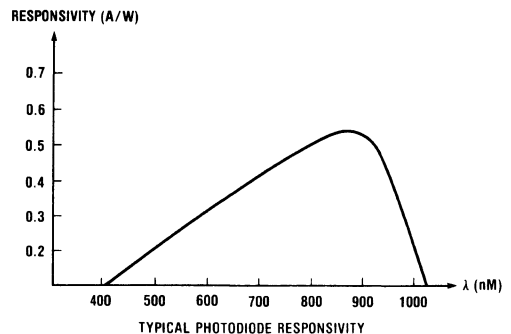
The PIN photodiode enhances the conventional photodiode's utility by producing the same amount of photocurrent from a lower capacitance source, thus giving higher speed operation. In normal operation, the entire intrinsic region is depleted, thus spreading apart the "plates" of the capacitor. Frequency response is typically to 1 GHz.

Avalanche Photodiode

The avalanche photodiode requires 150V to 300V of reverse bias to operate. Photo induced carriers are swept into a high field region where avalanche multiplication takes place. This produces front-end signal gain (50–500) without paying a speed penalty. Gain-bandwidth product of an avalanche photodiode is in the neighborhood of 100 GHz. The drawbacks to avalanche photodiodes are the high bias voltage needed, and the temperature compensation necessary for stable operation.

Responsivity

A photodiode's most fundamental characteristic is its responsivity, i.e., the amount of current it will produce in response to the incident light power. Responsivity is given in amperes per watt. *Figure 12* illustrates a typical responsivity versus wavelength for a silicon photodiode. The responsivity drops below 900 nm due to absorption, and above 900 nm due to the band gap of silicon (1.2 eV). A similar graph could be shown for a phototransistor or an avalanche photodiode. The y-axis would simply be multiplied by beta or the avalanche gain respectively. Note that when the incident light is measured in watts, the area of the detector does not play a part in the quantity of current produced. A photodiode whose responsivity at a given wavelength is 0.5 will produce 1 μ A in response to an incident light power of 2 μ W as long as all of the light falls on the photodiode's sensitive area. *Figure 13* gives a list of some of the manufacturers of photodiodes, phototransistors, and avalanche photodiodes.



TL/H/8748-13

FIGURE 12. Typical Photodiode Responsivity

DETECTOR MANUFACTURERS

ABORN

CENTRONIC

EG & G

HP

MATH ASSOCIATES

MERET

MOTOROLA

RCA

SPECTRONICS

TI

UNITED DETECTOR TECHNOLOGY

VALTEC

FIGURE 13. Detector Manufacturers

RECEIVER CIRCUITRY

The most challenging aspect of many fiber optic links is the design of the receiver. The receiver must convert the low level current output of a photodiode to a high level analog or digital signal with accuracy and speed.

Figure 14 illustrates the simplest of fiber optic receivers. The photodiode is back biased with a resistor to convert the photo-induced current to a voltage. Let us assume that we want to convert an input light power of 300 nW to a 15 mV signal. If the photodiode's responsivity is 0.5 A/W, then the photodiode will produce 150 nA, and for a 15 mV signal level, the resistor must be 100k. If the capacitance of the photodiode is 10 pF, then the rise time of the voltage output in response to a step light input will be approximately 2.2 μs. This also implies that our analog bandwidth is limited to a -3 dB frequency of 159 kHz.

How is it possible to obtain higher frequency performance at the same sensitivity without sacrificing signal-to-noise ratio? Decreasing the size of the resistor and using voltage amplifiers can achieve the same responsivity at a higher speed but it will sacrifice signal to noise ratio since a resistor's noise current contribution increases as the value of the resistor decreases. As we will see later, signal-to-noise is not only important for analog communication, but also sets the limiting bit error rate for digital signaling.

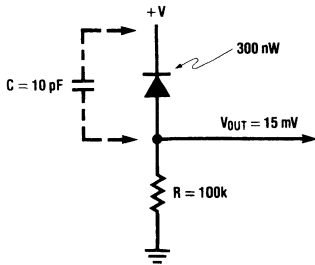
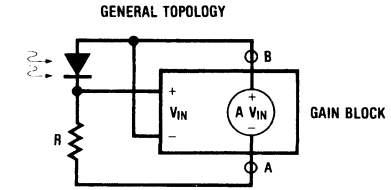


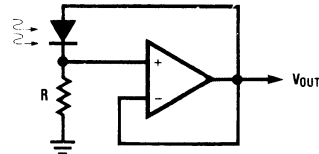
FIGURE 14. Simple Receiver

TL/H/8748-14

A single circuit topology can be practically applied in two ways to help us out. Figure 15 illustrates the general topology, with the first of the two specific implementations shown below. This is known as the bootstrap configuration as the function of the amplifier is to chase the voltage developed by the photocurrent flowing thru the resistor, and to apply this voltage to the opposite end of the photodiode. By keeping the voltage change across the photodiode's capacitance small, the effect of this reactance is reduced, and the circuit will respond faster. By rearranging the general topology once again, we arrive at the second implementation, known as the transimpedance approach as shown in Figure 16. Since the negative input of the amplifier can be considered a virtual ground, the voltage change across the photodiode's capacitance is kept small and thus its effect is reduced. The choice between either of the two approaches is left to the designer; however, the constraints placed on either of the amplifiers are the same when speed of response is used as the criterion.



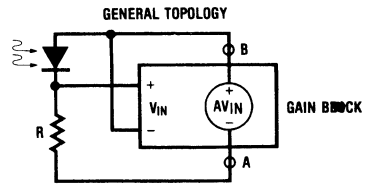
GROUND POINT A, AND CONSIDER B THE OUTPUT



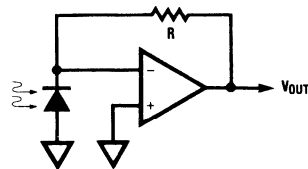
BOOTSTRAP CONFIGURATION

TL/H/8748-15

FIGURE 15. General Topology, Bootstrap Configuration



GROUND POINT B, AND CONSIDER A THE OUTPUT



TRANSIMPEDANCE CONFIGURATION

TL/H/8748-16

FIGURE 16. General Topology, Transimpedance Configuration

To give us an idea of how fast an amplifier we need to produce the desired speed of response, we will analyze the transimpedance circuit of *Figure 17*. We first define a time constant t that is equal to the product of the feedback resistor and lumped circuit capacitance C . C is the sum of stray capacitance, amplifier input capacitance and photodiode capacitance. The only other parameter to define is t_A , the inverse of the gain-bandwidth product of the amplifier. When we solve this simple circuit analysis problem, we find that the rise time of V_{OUT} is:

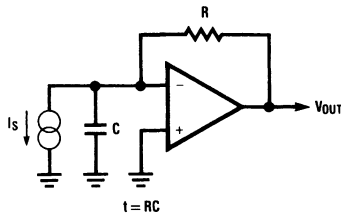
$$t_R = \pi\sqrt{t \times t_A}$$

$$t = RC, t_A = \frac{1}{2\pi(GBW)}$$

Rise time is chosen as the prime indicator of circuit speed performance as it allows us to make rapid calculations of the maximum bit rate for a digital communications link. The equation given above is an approximation as it assumes that the open loop gain of the amplifier is greater than 10 and $t < 2 A_{O}t_A$, where A_O is the open loop gain of the amplifier.

Returning to our original problem, how fast must our amplifier be to produce the desired overall fiber optic receiver speed? Let us use a specific example to determine the required amplifier speed. Suppose that we want to receive a 5 Mbit NRZ signal, our feedback resistor is 100k, and the circuit capacitance is 5.5 pF. From the data rate, we know that the rise time of the receiver must be 100 ns or less. Rearranging the above equation, we obtain:

$$\frac{1}{t_A} = \frac{\pi^2 t}{t_r^2}$$

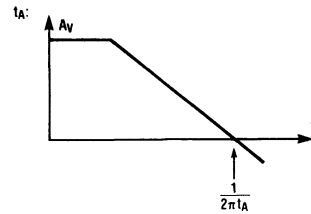


TL/H/8748-17

FIGURE 17. Equivalent Circuit and Amplifier Characteristic

When we plug in the numbers, we find that the gain-bandwidth of the amplifier must be 86 MHz! It's obvious that a 741-type amplifier with a gain-bandwidth of 1 MHz will not even come close to providing the speed we need. Fortunately, the LH0082 fiber optic receiver produced by National Semiconductor contains a preamp with a gain-bandwidth product of nearly 2 GHz. The LH0082 will provide the sensitivity and speed necessary for the example application, and it also includes a comparator for providing a TTL/DTL/CMOS compatible output. *Figure 18* is a block diagram of the LH0082. Two internal feedback resistors are included for use with the preamp to set sensitivity. External resistors can also be used. The output of the preamp is AC coupled to a comparator that can be connected as an edge triggered flip-flop. In this mode, the bit error rate can be set by the amount of hysteresis applied to the comparator. Using the internal hysteresis resistor, the bit error rate is better than 10^{-10} . The entire circuit operates from a single 4.5 to 5.5V power supply, although the preamp can be operated to 10V, and the comparator to 15V.

Figure 19 shows how to use the LH0082 as a 5 Mbit, 300 nW sensitivity fiber optic receiver. The only external components needed are the photodiode, a power supply decoupling resistor and two bypass capacitors.



TL/H/8748-18

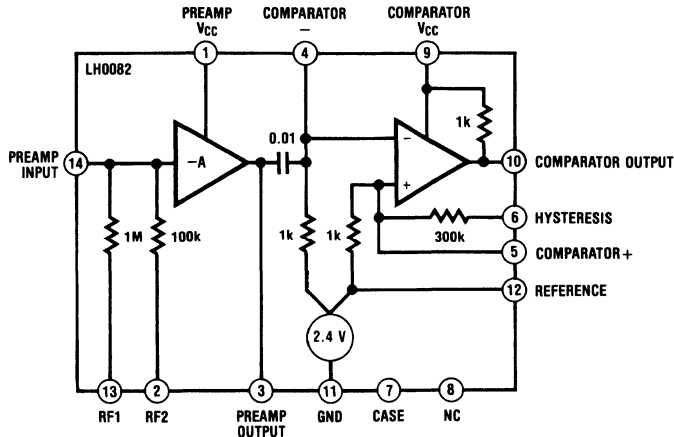


FIGURE 18. LH0082 Circuit Diagram

TL/H/8748-19

Bit Error Rate

The bit error rate (BER) is a very important consideration in any digital communications system; fiber optic data links are no exception. A BER of 10^{-10} means that one bit of 10 billion will be a bad bit. Obviously, the smaller the BER, the better off we are. There is a very simple relationship between the signal-to-noise ratio and the bit error rate. Given δ as the RMS noise voltage, A as the peak-to-peak signal level, and we determine the presence of one or a zero with a threshold of $A/2$, then the BER is:

$$BER = \frac{1}{2} \left(1 - \operatorname{erf} \frac{A}{2\sqrt{2}\delta} \right)$$

Where:

$$\operatorname{erf}(x) = \frac{2}{\sqrt{\pi}} \int_0^x e^{-y^2} dy$$

Figure 20 is a plot of this somewhat obtuse function. Note that we are guaranteed a BER of 10^{-10} with only 22 dB of signal-to-noise ratio. Thus, if we have a comparator threshold of 10 mV, a peak signal level of 20 mV, then the RMS noise must be less than 1.6 mV to give us 10^{-10} BER.

Stray Signal Pickup Problems

Although communication via fiber optic cable provides freedom from the effects of radio frequency interference, the circuitry at the receiver is not so fortunate. Let's take the example of the basic LH0082 300 nW sensitivity receiver. Assuming a 0.5 A/W photodiode, the LH0082 requires only 150 nA at its input to cause the comparator to switch states. Suppose that the output of a TTL gate is nearby and at that point the voltage can traverse 3V in as little as 5 ns. How much stray capacitance from this TTL output to the input of the LH0082 is needed to equal the signal level generated by the photodiode?

$$\text{Since } I = C \frac{dv}{dt}$$

$$\text{Then } C = C \frac{I dt}{dv}$$

$$C = C \frac{(150 \text{ nA})(5 \text{ ns})}{3V}$$

Thus $C = 2.5 \times 10^{-16} \text{F}$ or 0.00025 pF!!!

Although this may seem like an impossibly small amount of capacitance to live without, straightforward printed circuit board layout techniques can provide trouble-free operation.

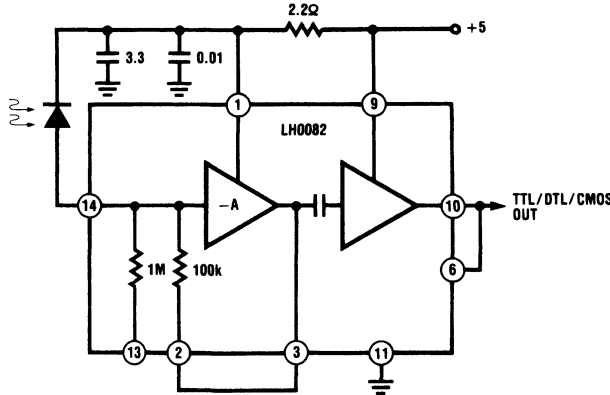


FIGURE 19. LH0082 Basic Operating Circuit—300 nW, 5 Mbit

TL/H/8748-20

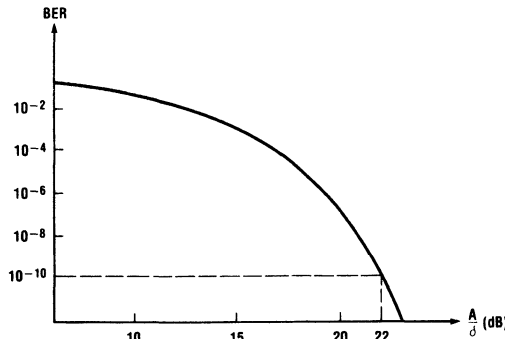


FIGURE 20. Bit Error vs. Signal-to-Noise Ratio

TL/H/8748-21

A COMPLETE LINK

Putting together a total link is not so difficult as the "experts" would have you believe. We can be almost sloppy in our handling of the transmitter circuitry, light coupling to transducers, and connecting the cable. The expense is a little care at the receiver end.

Figure 21 gives a sample application ideally suited to fiber optics. A data entry room is located 300 meters from a computer facility, separated by a manufacturing area containing arc welders, punch presses and the like. One-way communication from the three data entry terminals to the computer is required at 19.2 kbits. Let us assume that we will multiplex the three data channels with one sync. channel and send the signal through one fiber optic cable, and demultiplex the signal at the computer end. We will sample each of the three data channels and the sync. channel at 5 times the data rate or $4 \times 19,200 \times 5 = 384$ kbit data rate. We will select an inexpensive red indicator LED whose total output power is only $30 \mu\text{W}$ or -15 dBm. We must now account for all of the losses involved in transferring this light to the photodiode at the receiving end:

LED-transmitter connector:	- 10 dB
receiver connector:	- 3 dB
$300\text{M} \times \frac{40 \text{ dB}}{1000\text{M}}$ (cable):	- 12 dB
Safety Factor:	- 3 dB
Total loss =	- 28 dB

Thus, the power at the receiver is:

$$-15 \text{ dBm} - 28 \text{ dB} = -43 \text{ dBm} (50 \text{ nW})$$

The LH0082 in the high sensitivity mode ($R_F=1\text{M}$) has a 30 nW sensitivity with a 0.3 A/W photodiode and can provide a maximum data rate of 650 kbit . The use of inexpensive connectors, poor coupling of light to the fiber at the transmitter end, and cheap, moderate loss cable (40 dB/km) does not prohibit a high performance data link when used with a versatile receiver such as the LH0082.

CONCLUSION

Many such applications can be implemented by using cost effective, moderate performance LEDs, connectors and fiber optic cable by taking a little extra care with the receiver circuitry. The National Semiconductor LH0082 provides a versatile solution to such fiber optic receiver needs.

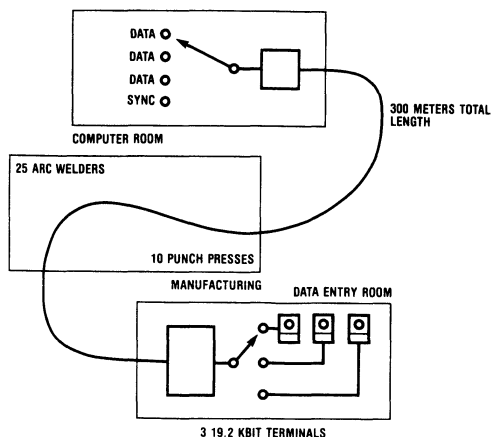


FIGURE 21. Sample System

TL/H/8748-22

Application of the ADC1210 CMOS A/D Converter

National Semiconductor
Application Note 245



INTRODUCTION

The ADC1210 is the answer to a need for analog to digital conversion in applications requiring low power, medium speed, or medium to high accuracy for low cost. The versatile input configurations allow many different input scale ranges and output logic formats.

The wide supply voltage range of 5V to 15V readily adapts the device to many applications. The very low power dissipation yields remarkable conversion linearity over the full operating temperature range. Table I below summarizes the typical performance of the ADC1210.

TABLE I. ADC1210 Performance Characteristics

Resolution	12 bits
Linearity Error, $T_A = 25^\circ\text{C}$	$\pm 0.0183\%$ FS MAX
Over Temperature	$\pm 0.0366\%$ FS MAX
Full Scale Error, $T_A = 25^\circ\text{C}$	0.2% FS MAX
Zero Scale Error, $T_A = 25^\circ\text{C}$	0.2% FS MAX
Quantization Error	$\pm 1/2$ LSB MAX
Conversion Time	200 μs MAX

This note expands the scope of application configurations and techniques beyond those shown in the data sheet. The first section discusses the theory of operation. The remaining sections are devoted to applications that extract the optimum potential from the ADC1210.

THEORY OF OPERATION

Like most successive approximation A to D's, the ADC1210 consists of a successive approximation register (SAR), a D to A converter, and a comparator to test the SAR's output against the unknown analog input. In the case of the ADC1210, these elements are connected to allow unusual versatility in matching performance to the user's applications.

The SAR is a specialized shift register programmed such that a start pulse applies a logical low to the most significant bit (MSB) and logical highs to all other bits, thus applying a half scale digital signal to the DAC. If the comparator finds that the unknown analog input is below half scale, the low is shifted to the second bit to test for quarter scale. If, on the other hand, the comparator finds that the analog input is above half scale, the "low" state is not only shifted to the second bit, but also retained in the MSB, thus forming the digital code for three quarters scale. Upon completing the quarter (or three-quarter) scale test, the next clock pulse sets the SAR to test either $1/8$, $3/8$, $5/8$, or $7/8$ full scale, depending on the input and the previous decisions. This successive half-the-previous-scale approximation sequence continues for the remaining lower order bits. The thirteenth clock pulse shifts the test bit off the end of the working register and into the conversion complete output. *Figure 1* shows the schematic diagram of the device.

OPERATING CONFIGURATIONS

Figures 2 through *5* show four operating configurations in addition to those presented in the data sheet.

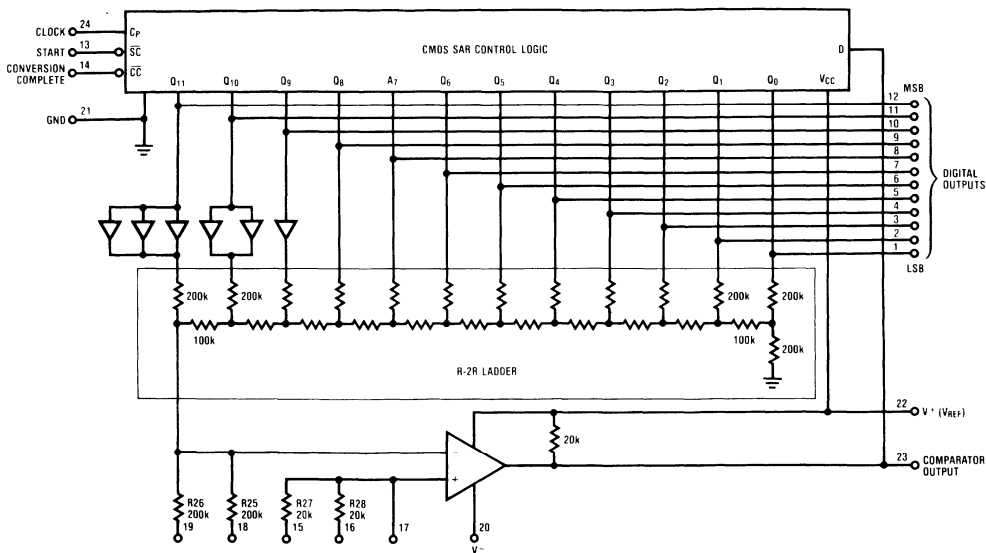
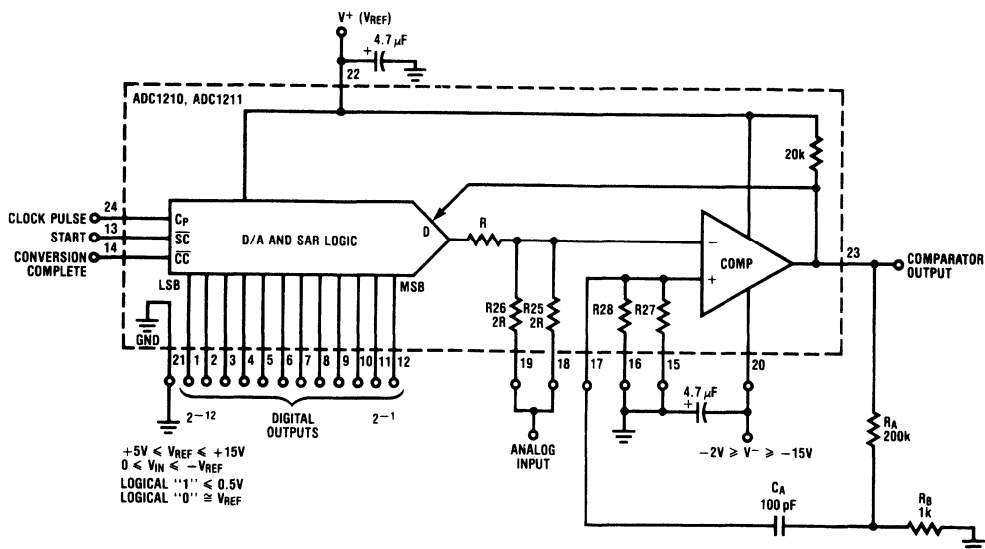
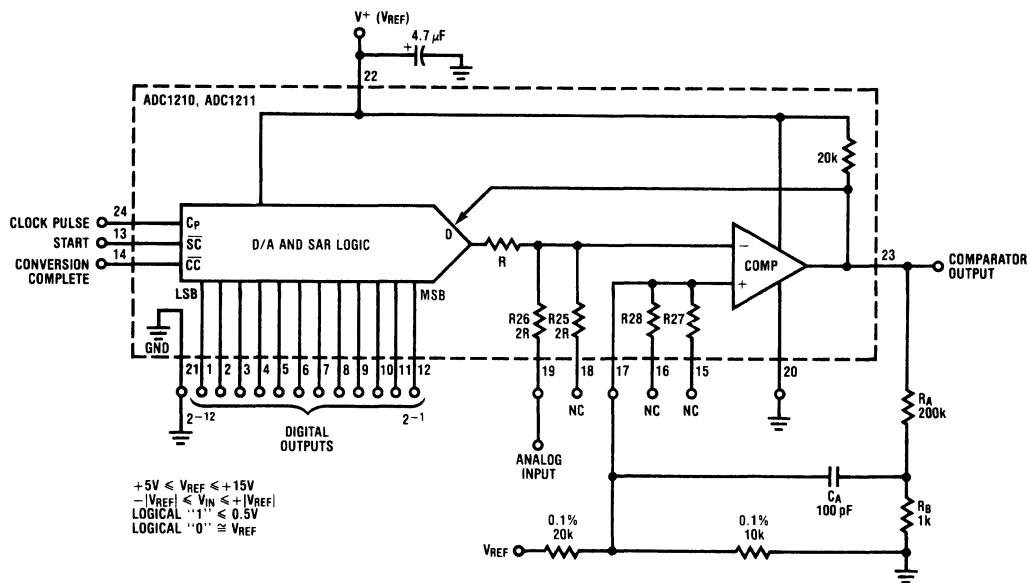


FIGURE 1. Schematic Drawing

TL/H/7185-1

FIGURE 2. Complementary Logic, 0V to $-V_{REF}$ Input

TL/H/7185-2

FIGURE 3. Complementary Logic, Bipolar $-V_{REF}$ to $+V_{REF}$ Input

TL/H/7185-3

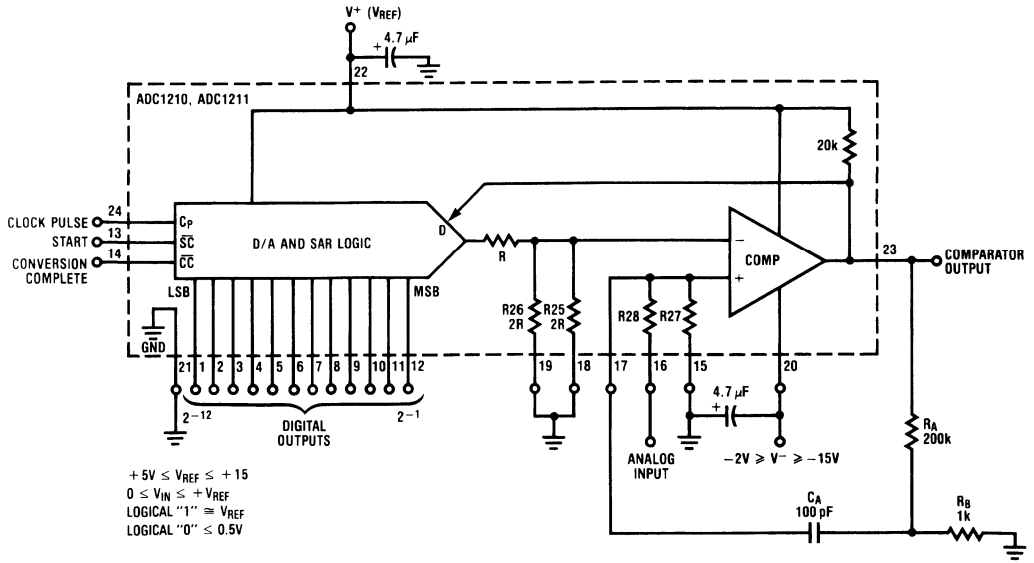


FIGURE 4. Positive True Logic, 0V to +V_{REF} Input

TL/H/7185-4

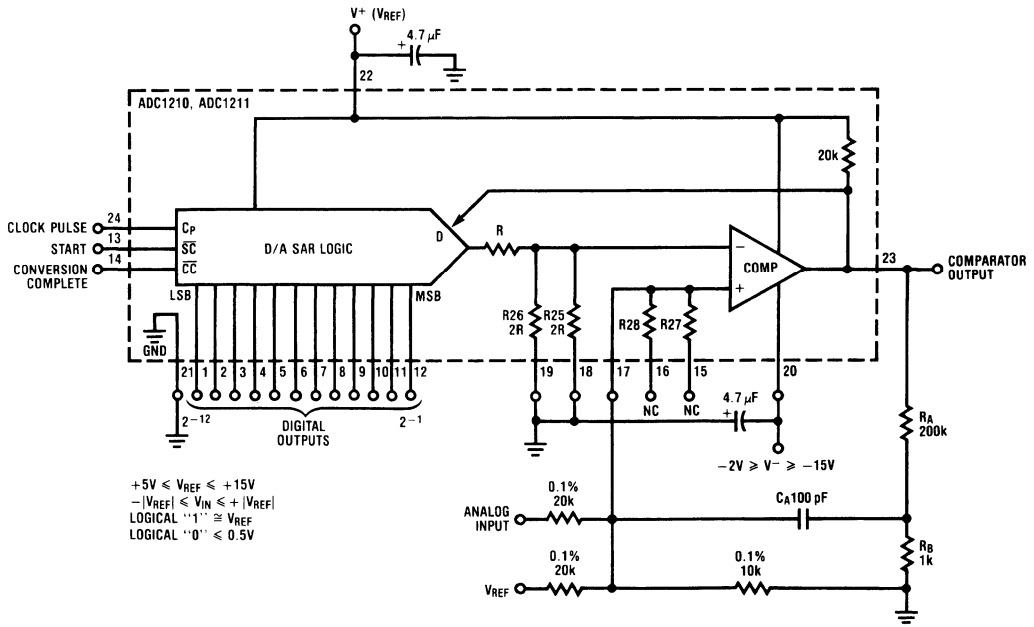


FIGURE 5. Positive True Logic, Bipolar -V_{REF} to +V_{REF} Input

TL/H/7185-5

DESIGN CONSIDERATIONS

To Complement, or Not to Complement

Of the two recommended logic configurations, the complementary version is preferred. It provides greater accuracy than the straight binary version. The reason for that is that with the complementary logic configuration, a reference voltage is fixed at the non-inverting input of the comparator. Consequently, the comparator operates at this fixed threshold independent of the input voltage. For the straight binary configuration, the analog input drives the non-inverting input of the comparator so that the common mode voltage on the comparator input varies with the analog input. This adds a non-linear offset voltage of less than $\frac{1}{4}$ LSB.

Regardless which configuration is used, the comparator input common mode range must not be exceeded. In fact, the voltage at either comparator input must be no less than 0.5 volts from the negative supply and 2.0 volts from the positive supply. Therefore, for applications requiring common mode range to ground, simply connect a negative supply ($-2V$ to $-15V$) to pin 20.

Layout Considerations

High resolution D/A and A/D converter circuits may have their entire error budget blown if any digital noise is allowed to enter the analog circuit.

Exercising care in the layout is certain to minimize frustrations. Single point analog grounding is a good place to start. All analog ground connections and supply bypassing should be returned to this point. In fact, in critical applications, the ADC1210 GND pin should be made "the" reference node. Furthermore, one should separate the analog ground from the digital ground. Any excursion of switching spikes generated in the digital circuit is, to some degree, decoupled from the analog circuitry. Figure 6 illustrates this. Of course, these two points are eventually tied together at the power supply/chassis common.

In addition to a good ground system, it is a good idea to keep digital signal traces as far apart from the analog input as is practical in order to avoid signal cross coupling.

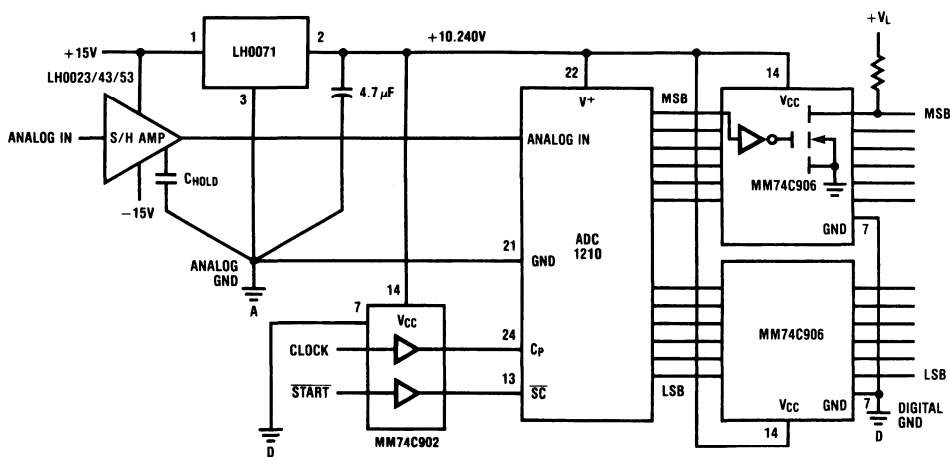


FIGURE 6. Grounding Considerations of Interface Circuits

TL/H/7185-6

Power Supply Bypassing

The supply input only provides power to the digital logic, it is also a reference voltage to the resistor ladder network of the ADC1210. This voltage must be a very stable source. A precision reference device such as the LH0070 or LH0071 is ideal for the ADC1210. However, the internal CMOS Successive Approximation Register (SAR) invariably generates current spikes (10–20 mA peak) in the supply pin as the logic circuit switches past the linear region. Consequently, if a reference device such as the LH0070 is used, the current spike tends to cause excursions in the reference voltage, thus threatening conversion accuracy. To preserve the 12-bit accuracy, bypass the supply pin with a 4.7 μF tantalum capacitor. In high noise environments, a 22 μF capacitor shunted by a 0.1 μF ceramic disc capacitor is desirable.

If pin 20 is connected to a negative supply, it too should be bypassed to prevent voltage fluctuations from affecting the comparator operation.

Output Drive Capability

The digital outputs of the ADC1210 and the outputs of the SAR, through which the resistor ladder is referenced, are one and the same. Any excessive load current on the digital output lines will degrade conversion accuracy. For this reason, the ADC1210 must interface with CMOS logic. However, the three most significant bits (pins 10, 11, and 12) are buffered from the R-2R ladder and are capable of driving light loads without degrading linearity. This could prove useful in 2's complement applications where an inverter is necessary in the MSB; one might construct this inverter with a discrete NPN transistor and two resistors. The bit most sensitive to output loading is the fourth most significant (pin 9). An error voltage at this pin gets divided down by a factor of 16 before being applied to the comparator, so if we wish to limit the error due to output loading to say, $\frac{1}{2}$ LSB, or 1.25 mV at the comparator, we can tolerate 20 mV at pin 9. If all lower bits will have the same output load, the error must be limited to 10 mV. Since all of the digital outputs have a maximum ON resistance of 350 Ω at 10V V_{REF} in both high and low states, the maximum allowable load current is $10 \text{ mV} / 350 \Omega = 29 \mu\text{A}$. This current requirement is easily satisfied with an MM74C914 or MM74C901 thru MM74C902 level translators for interface with logic levels different than V_{REF} .

Comparator Hysteresis

Even an ideal comparator can be expected to oscillate due to stray capacitive feedback if biased in the linear region. It is the normal operation of the SAR feedback loop to do just that . . . at least at or toward the end of the conversion cycle. For most applications, this oscillation is only a minor bother, as the SAR register would have locked out the converted data from further changes at the end of conversion. If that is still undesirable, the Conversion Complete (CC) Signal may be used to drive an open-collector gate (such as the MM74C906) with the output wire-ORed to the comparator output. In this way, the comparator is always clamped to the low state at the end of conversion. Normal operation resumes upon restart of a new conversion cycle.

In normal operation, however, if we want to preserve 12-bit accuracy, the comparator oscillation should be suppressed.

The recommended technique is to apply a slight amount of AC hysteresis (50 mV) at the beginning of the decision cycle, but let it decay away to an acceptable accuracy before the decision is actually recorded in the SAR. The approximate decay time is $(5) \times (10\text{k} + 1\text{k}) \times (100 \text{ pF})$, or 5.5 μs (see Figure 2).

For those applications using supply voltage other than 10V, say 5V, and if 50 mV initial hysteresis is to be maintained, the 200 k Ω (R_A) resistor in Figure 2 should be changed to 100 k Ω based on the relationship:

$$\frac{R_B}{R_A + R_B} V_{\text{REF}} = 50 \text{ mV}$$

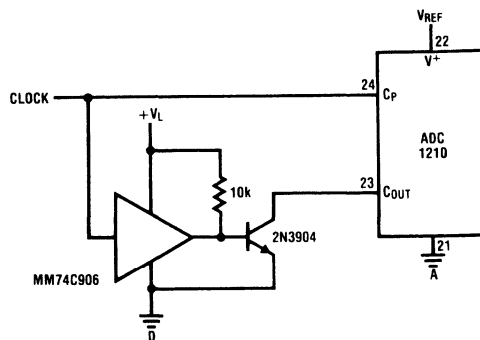
Where: $R_B = 1 \text{ k}\Omega$

High Speed Conversion Technique

By using one IC, one discrete NPN transistor, and a resistor, the ADC1210 can be made to run at up to 500 kHz clock frequency, or 12-bit conversion time of 26 μs . The circuit is shown in Figure 7. The idea is to clamp the comparator output low until the SAR is ready to strobe in the data at the rising edge of the conversion clock. Comparator oscillation is suppressed and kept from influencing the conversion decisions. This technique eliminates the need for the AC hysteresis circuit.

To implement the idea, a complementary phased clock is required. The positive phase is used to clock the converter SAR as is normally the case. The inverted clock, generated from the same clock signal, is inverted by the transistor. The open collector is wire-ORed to the output of the comparator. During the first half of the clock cycle (50% duty cycle), the comparator output is clamped and disabled, though its internal operation is still in working order. During the last half cycle, the comparator output is unclamped. Thus, the output is permitted to slew to the final logic state just before the decision is logged into the SAR. The MM74C906 buffer (or with two inverting buffers) provides adequate propagation delay such that the comparator output data is held long enough to resolve any internal logic set-up time requirements.

The 500 kHz clock implies that the absolute minimum amount of time required for the comparator output to be unclamped is 1 μs . Therefore, for applications with clock signal other than 50% duty cycle, this 1 μs period must be observed.



TL/H/7185-7

FIGURE 7. High Speed Conversion Circuit

Testing has demonstrated reliable performance from this circuit beyond the recommended device operating frequency of 65 kHz. However, the AC hysteresis circuit is still a very reliable technique below this clock frequency and, therefore, should be used. Only in applications where the required clock frequency is above 65 kHz should the above-mentioned technique be adopted.

Synchronizing Conversion Start Signal

It is recommended that the START CONVERT input be synchronized to the CLOCK input. This avoids the possibility of the comparator making an error on the first (MSB) decision when the analog input is near $\frac{1}{2}$ scale. There is a chance that energy can be coupled to the comparator from the rising edge of the START signal. If this occurs just before the rising edge of the clock, a wrong MSB decision can be made if time is not allowed for the charge to dissipate. The synchronization circuit in Figure 8 effectively prevents this from occurring.

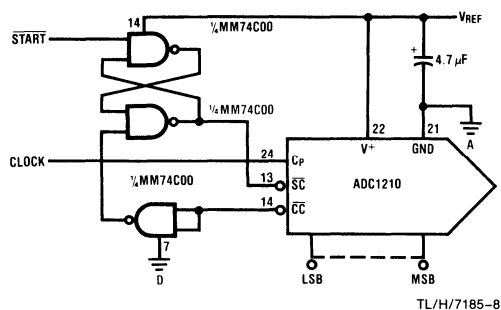


FIGURE 8. Synchronizing START CONVERT Signal

The circuit operates as follows: initially the latch is in the RESET state and the converter is in the end-of-conversion state (\overline{CC} output at logic low). The START signal sets the latch and, on the next positive clock transition, initializes all internal registers in the converter. The \overline{CC} output is set to logic high, presetting the external latch. The latch is held in the "RESET" state during the entire conversion period, effectively preventing a new START signal from interrupting the conversion.

Serial Output

The comparator output does contain the stream of serially converted data with the most significant bit first. However, recognizing the danger of comparator oscillation, there is a potential for the external serial data register to latch a data bit different from that recorded in the SAR due to different logic set-up time requirements. If the ADC1210 accepts an error in any one data bit, the subsequent lower order bits tend to correct for it. On the other hand, an external serial register has no provision for error correction. All subsequent bits following a bit in error will not be valid data.

The 12 bits of information can be shifted out serially by using an MM74C150 digital multiplexer. The circuit is shown in Figure 9. This scheme permits valid data to be available at the serial output port as fast as half a clock cycle after the most current decision. The data are thus synchronized to the converter clock (here the serial data are synchronized at the falling edge of the system CLOCK, to avoid clock skew). Obviously, a number of variations can be made to this basic circuit for use with different handshake protocols.

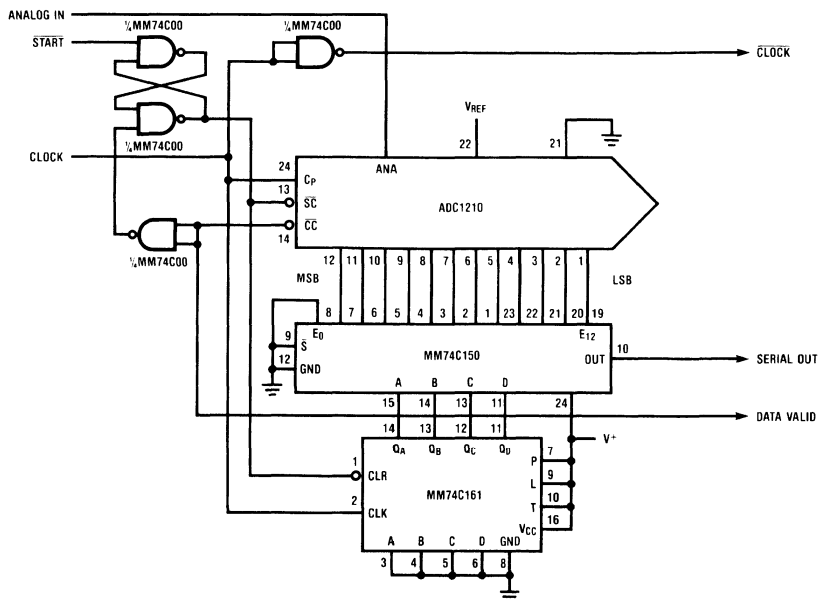


FIGURE 9. 12-Bit A/D Converter with Serial Output

TL/H/7185-9

APPLICATIONS

Long Time Sample and Hold

The circuit in *Figure 10* is a particularly simple realization of an infinite sample and hold. This scheme requires two low-cost analog sample-and-hold amplifiers to complete the circuit.

The idea is to utilize the digital-loop feedback mechanism of the ADC1210 which, in the normal conversion mode, replicates the analog input voltage at the output of the SAR/D-to-A converter.

The operation of the circuit may be described as follows: During the normal "hold" mode, the replicated analog voltage is buffered straight through the S/H amplifier to the output. Upon an issuance of a SAMPLE signal, this S/H amplifier is placed in the hold mode, holding the voltage until the new analog voltage is valid. The same SAMPLE signal triggers an update to the input sample-and-hold amplifier. The most current analog voltage is captured and held for conversion. This way, the previously determined voltage is held stable at the output during the conversion cycle while the SAR/D-to-A continuously adjust to replicate the new input voltage. At the end of the conversion, the output sample-and-hold amplifier is once again placed in the track mode. The new analog voltage is then regenerated.

An Auto-Ranging Gain-Programmed A/D Converter

The circuit in *Figure 11* shows one possible circuit of an auto-ranging A/D converter. The circuit has a total of 8 gain ranges, with the ranging done in the LH0086 Programmable Gain Amplifier (for differential input, use the LH0084 with ranges of 1, 2, 5, 10 digitally programmed, or pin strap programmed for multiplying factors of 1, 4, and 10). The gain ranges are: 1, 2, 5, 10, 20, 50, 100, and 200. It effectively improves the A/D resolution from 12 bits to an equivalent of 19 bits, a dynamic range of better than 100 dB.

The circuit has relatively high speed ranging due to the very fast settling time of the LH0086, typically 5 μ s for 10V

swing, well within the 15 μ s converter clock period. Thus, the ranging circuit is designed to work off the same clock.

The circuit is designed such that the auto-ranging function is transparent to the user. All command signals into and out of the system are identical to those of an ADC1210 operating alone. The only exception is that the system requires one and one-half clock cycle (mandatory auto range cycle), plus however many ranges it has to scale to (each scale requires one clock period, 7 possible range switching in all) in addition to the basic 13 conversion cycle required by the ADC1210. Therefore, in the best case where no ranging is necessary, the circuit adds 22.5 μ s to the conversion time; and in the worst case, an additional 128 μ s.

In the quiescent state where the ADC1210 is in the non-conversion mode, the auto-ranging circuit is free to function normally. Upon an issuance of a START signal, the next clock rising edge puts the circuit in the final auto range cycle before conversion begins. If the need for up-range or down-range is detected, the circuit remains in the auto range mode until all necessary scaling is completed. The control circuit then issues a start conversion signal to the ADC1210. Half a clock cycle later, the ADC1210 begins conversion and suspends the auto-ranging operation until the conversion is completed. At which time the 12-bit converter data plus the 3-bit range data are valid for further processing.

This design is suitable for applications in data-acquisition systems or portable instruments, particularly where low power is an important consideration. Other variations from this basic scheme can be realized depending on the user's requirements.

SUMMARY

The ADC1210 is a low-cost, medium-speed CMOS analog-to-digital converter with 12-bit resolution and linearity. It has wide supply range and flexible configuration to allow varied applications such as field instruments and sampled data systems.

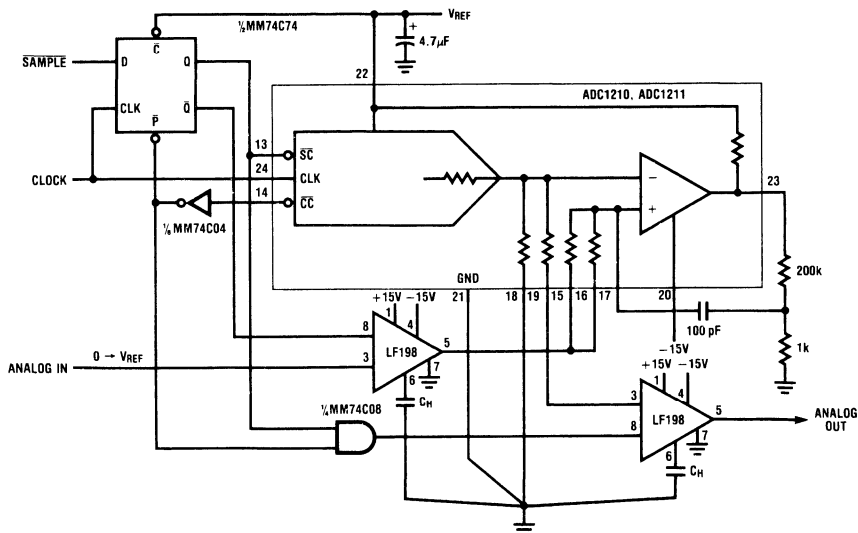


FIGURE 10. Infinite Sample and Hold Amplifier

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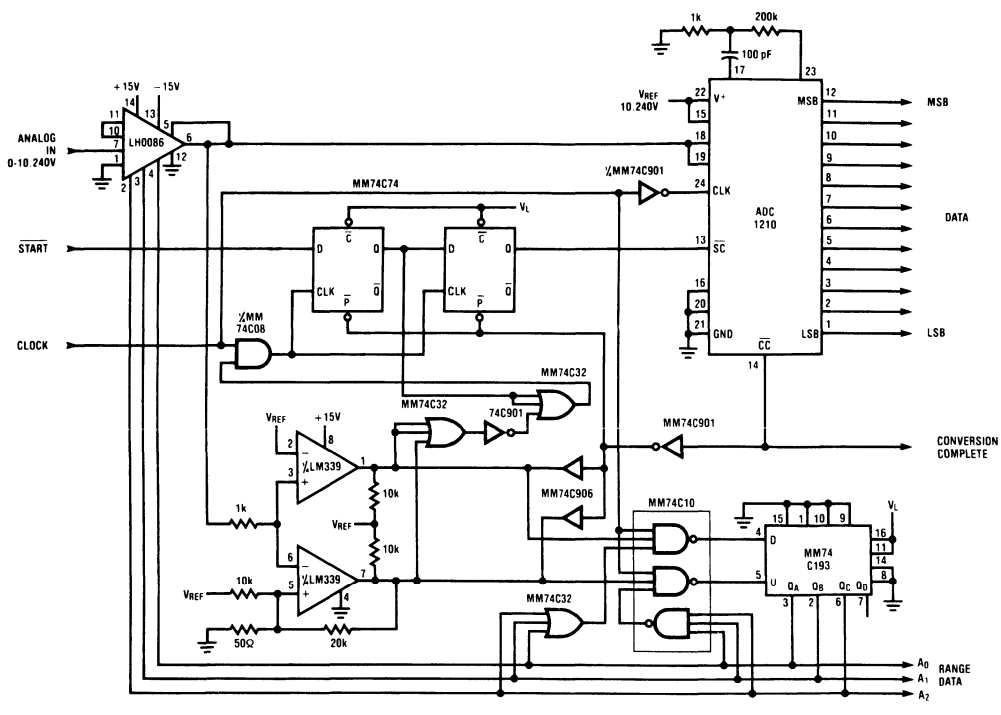


FIGURE 11. Auto Gain Ranging A/D Converter

TL/H/7185-11

Using the ADC0808/ ADC0809 8-Bit μ P Compatible A/D Converters with 8-Channel Analog Multiplexer

National Semiconductor
Application Note 247
Larry Wakeman



INTRODUCTION

The ADC0808/ADC0809 Data Acquisition Devices (DAD) implement on a single chip most the elements of the standard data acquisition system. They contain an 8-bit A/D converter, 8-channel multiplexer with an address input latch, and associated control logic. These devices provide most of the logic to interface to a variety of microprocessors with the addition of a minimum number of parts.

These circuits are implemented using a standard metal-gate CMOS process. This process is particularly suitable to applications where both analog and digital functions must be implemented on the same chip.

These two converters, the ADC0808 and ADC0809, are functionally identical except that the ADC0808 has a total unadjusted error of $\pm 1/2$ LSB and the ADC0809 has an unadjusted error of ± 1 LSB. They are also related to their big brothers, the ADC0816 and ADC0817 expandable 16 channel converters. All four converters will typically do a conversion in $\sim 100 \mu\text{s}$ when using a 640 kHz clock, but can convert a single input in as little as $\sim 50 \mu\text{s}$.

1.0 FUNCTIONAL DESCRIPTION

The ADC0808/ADC0809, shown in *Figure 1*, can be functionally divided into 2 basic subcircuits. These two subcircuits are an analog multiplexer and an A/D converter. The multiplexer uses 8 standard CMOS analog switches to provide for up to 8 analog inputs. The switches are selectively turned on, depending on the data latched into a 3-bit multiplexer address register.

The second function block, the successive approximation A/D converter, transforms the analog output of the multiplexer to an 8-bit digital word. The output of the multiplexer goes to one of two comparator inputs. The other input is derived from a $256R$ resistor ladder, which is tapped by a MOSFET transistor switch tree. The converter control logic controls the switch tree, funneling a particular tap voltage to the comparator. Based on the result of this comparison, the control logic and the successive approximation register (SAR) will decide whether the next tap to be selected should be higher or lower than the present tap on the resistor ladder. This algorithm is executed 8 times per conversion, once every 8 clock periods, yielding a total conversion time of 64 clock periods.

When the conversion cycle is complete the resulting data is loaded into the TRI-STATE[®] output latch. The data in the output latch can then be read by the host system any time before the end of the next conversion. The TRI-STATE capability of the latch allows easy interface to bus oriented systems.

The operation of these converters by a microprocessor or some control logic is very simple. The controlling device first selects the desired input channel. To do this, a 3-bit channel address is placed on the A, B, C input pins; and the ALE input is pulsed positively, clocking the address into the multiplexer address register. To begin the conversion, the START pin is pulsed. On the rising edge of this pulse the internal registers are cleared and on the falling edge the start conversion is initiated.

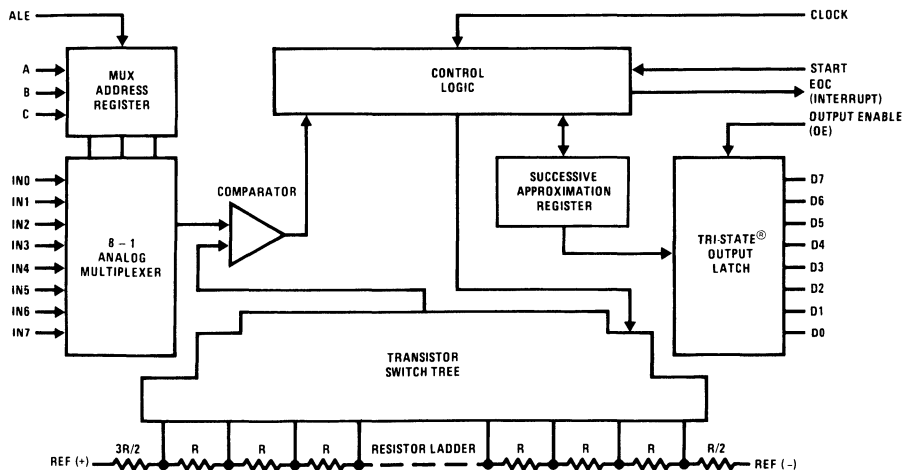


FIGURE 1. ADC0808/ADC0809 Functional Block Diagram

TL/H/5623-1

As mentioned earlier, there are 8 clock periods per approximation. Even though there is no conversion in progress the ADC0808/ADC0809 is still internally cycling through these 8 clock periods. A start pulse can occur any time during this cycle but the conversion will not actually begin until the converter internally cycles to the beginning of the next 8 clock period sequence. As long as the start pin is held low no conversion begins, but when the start pin is taken low the conversion will start within 8 clock periods.

The EOC output is triggered on the rising edge of the start pulse. It, too, is controlled by the 8 clock period cycle, so it will go low within 8 clock periods of the rising edge of the start pulse. One can see that it is entirely possible for EOC to go low before the conversion starts internally, but this is not important, since the positive transition of EOC, which occurs at the end of a conversion, is what the control logic is looking for.

Once EOC goes high this signals the interface logic that the data resulting from the conversion is ready to be read. The output enable (OE) is then raised high. This enables the TRI-STATE outputs, allowing the data to be read. Figure 2 shows the timing diagram.

2.0 ANALOG INPUTS

2.1 Ratiometric Inputs

The arrangement of the REF(+) and REF(-) inputs is intended to enable easy design of ratiometric converter systems. The REF inputs are located at either end of the 256R resistor ladder and by proper choice of the input voltages several applications can be easily implemented.

Figure 3 shows a typical input connection for ratiometric transducers. A ratiometric transducer is a conversion device whose output is proportional to some arbitrary full-scale value. In other words, the transducer's absolute output value is of no particular concern but the ratio of the output to the

full-scale is of great importance. For example, the potentiometric displacement transducers of Figure 3 have this feature. When the wiper is at midscale, the output voltage is $V_O = V_F \times (\text{Wiper Displacement}) = V_F \times 0.5$. This enables the use of much less accurate and less expensive references. The important consideration for this reference is noise. The reference must be "glitch free" because a voltage spike during a conversion cycle could cause conversion inaccuracies.

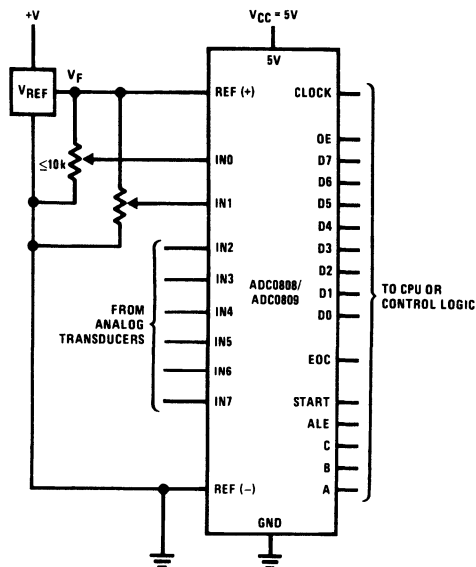


FIGURE 3. Ratiometric Converter with Separate Reference

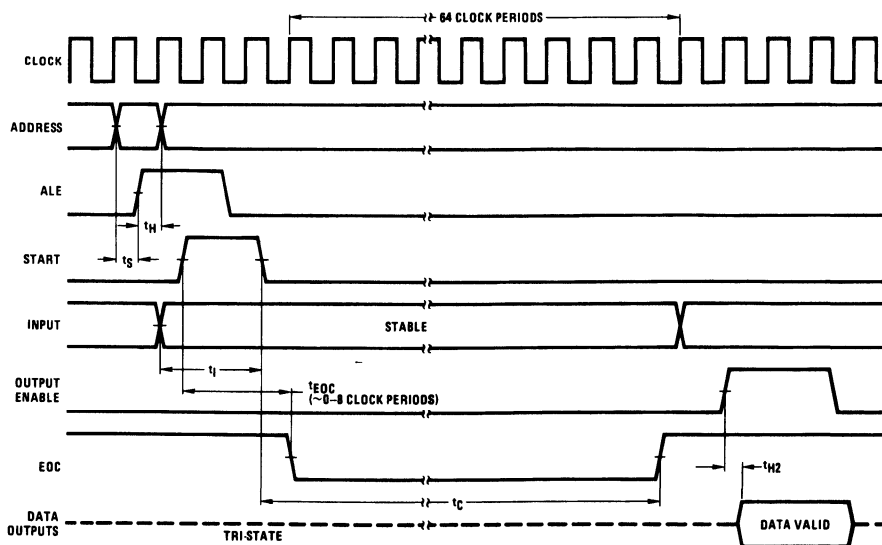


FIGURE 2. ADC0808/ADC0809 Timing Diagram

TL/H/5623-2

Since highly accurate references aren't required it is possible to use the system power supply as a reference, as shown in *Figure 4*. If the power supply is to be used in this manner supply noise must be kept to a minimum to preserve conversion accuracy. If possible the supply should be well bypassed and separate reference and supply PC board traces, originating as close as possible to the power supply or regulator, should be used. This is illustrated in *Figure 4*. External accessibility of both ends of the resistor ladder enables several variations on these basic connections, and

are shown in *Figures 5* and *6*. The magnitude of the reference voltage, $V_{REF} = REF(+) - REF(-)$, can be varied from about $\sim 0.5V$ to V_{CC} , but the center voltage must be maintained within $\pm 0.1V$ of $V_{CC}/2$. This constraint is due to the design of the transistor switch tree, which could malfunction if the offset from center scale becomes excessive. Variation of the reference voltage can sometimes eliminate the need for external gain blocks to scale the input voltage to a full-scale range of 5V.

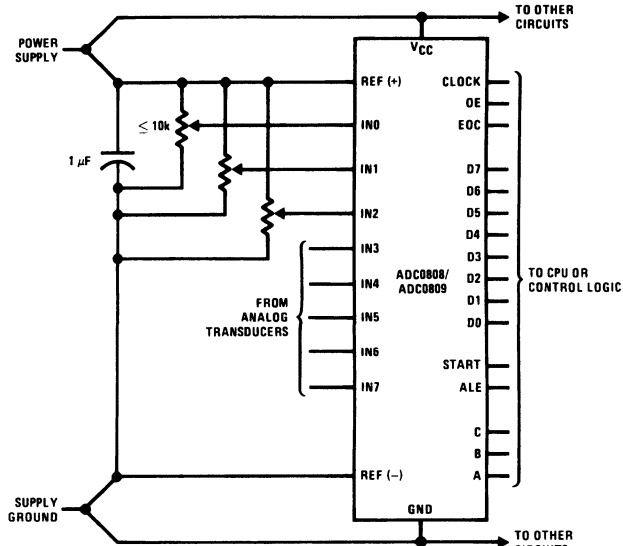


FIGURE 4. Ratiometric Converter with Power Supply Reference

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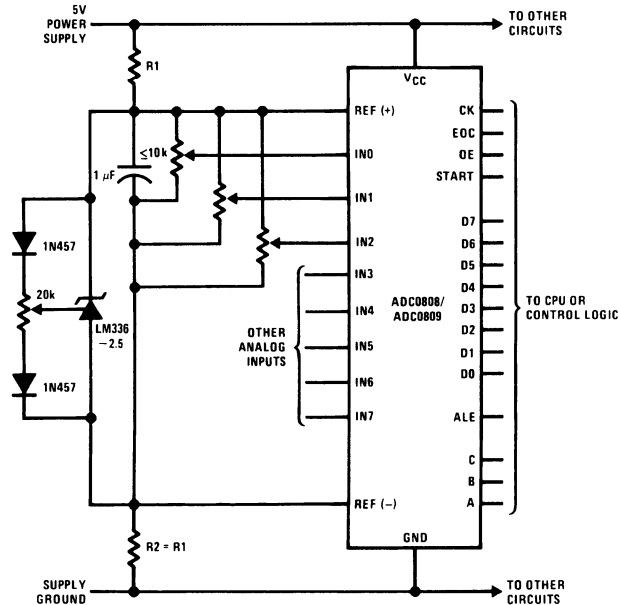
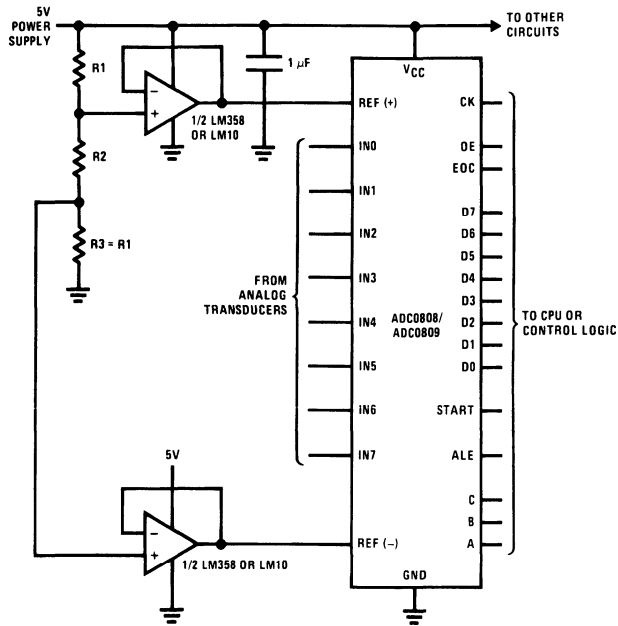


FIGURE 5. Mid-Supply Centered Reference Using LM336 2.5V Reference

TL/H/5623-3



TL/H/5623-4

FIGURE 6. Mid-Supply Centered Reference Using Buffered Resistors

Figure 5 shows a center referencing technique, using two equal resistors to symmetrically offset an LM336 2.5V reference, from both supplies. The offset from either supply is:

$$V_{OFF} = \frac{V_{CC} - V_{REF}}{2} = 1.25V$$

These resistors should be chosen so that they limit current through the LM336 to a reasonable value, say 5 mA. The total resistor current is:

$$I_R = I_{REF} + I_{LADDER} + I_{TRAN}$$

where I_{LADDER} is the 256R ladder current, I_{TRAN} is the current through all the transducers, and I_{REF} is the current through the reference. R1 and R2 should be well matched and track each other over temperature.

For odd values of reference voltage, the reference could be replaced by a resistor, but due to loading and temperature problems, these resistors should be buffered to the REF(+) and REF(-) inputs, Figure 6. The power supply must be well bypassed as supply glitches would otherwise be passed to the reference inputs. The reference voltage magnitude is:

$$V_{REF} = V_{DD} \left(\frac{R2}{2R1 + R2} \right) \text{ For } R3 = R1$$

There are several op amps that can be used for buffering this ladder. Without adding another supply, an LM358 could be used if the REF(+) input is not to be set above 3.5V. The LM10 can swing closer to the positive supply and can be used if a higher $V_{REF(+)}$ voltage is needed.

As the REF(+) to REF(-) voltage decreases the incremental voltage step size decreases. At 5V one LSB represents ~20 mV, but at 1V, one LSB represents ~4 mV.

As the reference voltage decreases, system noise will become more significant so greater precaution should be enforced at lower voltages to compensate for system noise; i.e., adequate supply and reference bypassing, and physical as well as electrical isolation of the inputs.

2.2 Absolute Analog Inputs

The ADC0808/ADC0809 may have been designed to easily utilize ratiometric transducers, but this does not preclude the use of non-ratiometric inputs. A second type of input is the absolute input. This is one which is independent of the reference. This implies that its *absolute* numerical voltage value is very critical, and to accurately measure this voltage the accuracy of the reference voltage becomes equally critical. The previous designs can be modified to accommodate absolute input signals by using a more accurate reference. In Figure 4 the power supply reference could be replaced by LM336-5.0 reference. R1 and R2 of Figure 6, and R1 and R3 of Figure 7 may have to be made more accurately equal.

In some small systems it is possible to use the precision reference as the power supply as shown in Figure 7. An unregulated supply voltage >5V is required, but the LM336-5.0 functions as both a regulator and reference. The dropping resistor R must be chosen so that, for the whole range of supply currents needed by the system, the LM336-5.0 will stay in regulation. As in Figure 4 separate supply and reference traces should be used to maintain a noiseless supply.

If the system requires more power, an op amp can be used as shown in Figure 8 to isolate the system and boost the supply current capabilities. Here again, a single unregulated supply is required.

2.3 Differential Inputs

Differential measurements can be obtained by playing a little software trick. This simply involves sequentially converting two channels then subtracting the two results. For example, if the difference voltage between channel 1 and 2 is required, merely convert channel 1 and read the result. Then convert channel 2, input the result, and subtract it

from the first result. (See *Figure 9.*) When using this procedure, both input signals must be stable throughout both conversion times or the end result will be incorrect. One way to get around this is to use two sample/holds which are sampled at the same time.

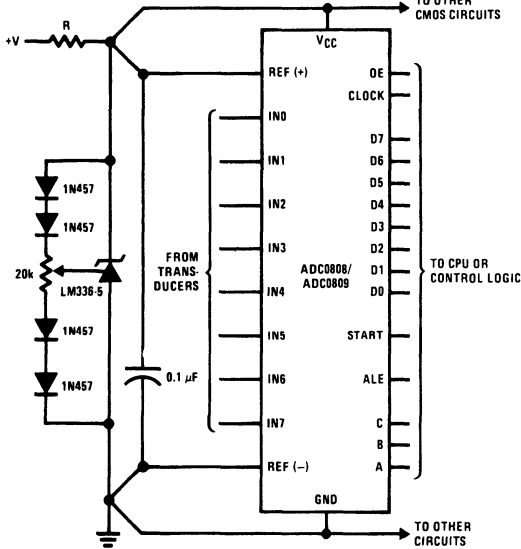


FIGURE 7. Precision Reference used as a Power Supply

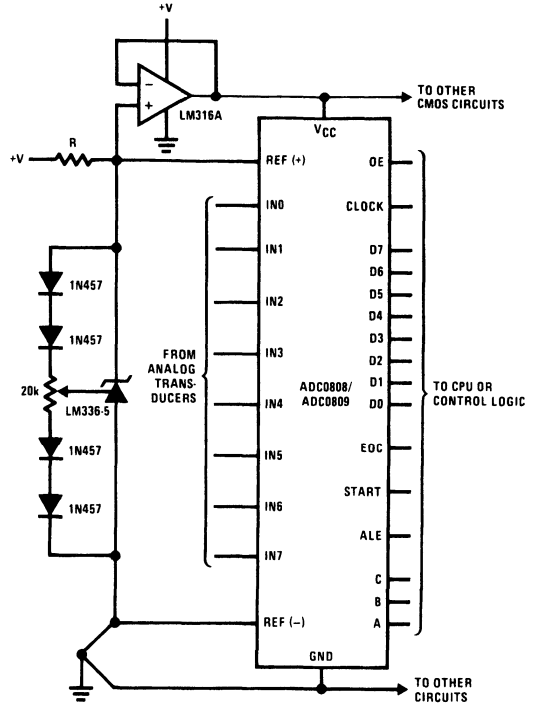


FIGURE 8. Precision Reference Buffered for Power Supply

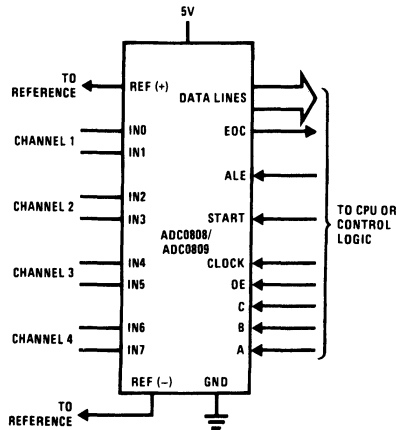


FIGURE 9. Software Controlled Differential Converter

A second method is to use two chips to convert a differential channel, *Figure 10*. Typically each channel 1 would be connected to opposite sides of the differential input. Both converters are started simultaneously. When both converters' EOC outputs go high the output of the AND gate will go high indicating that the data is ready to be read.

The circuit in *Figure 10* can be slightly modified to provide increased data throughput by using two converters in a

parallel data acquisition scheme. *Figure 11* shows this circuit in which all the input channels are connected in pairs through LF398 monolithic sample/holds. Under normal operation a sample/hold is accessed through an MM74C42 which will pulse an MM74C221, generating a sample pulse. After a sample/hold is done sampling the signal, the appropriate channel is started. If this process is alternated between two converters the sample rate can be doubled.

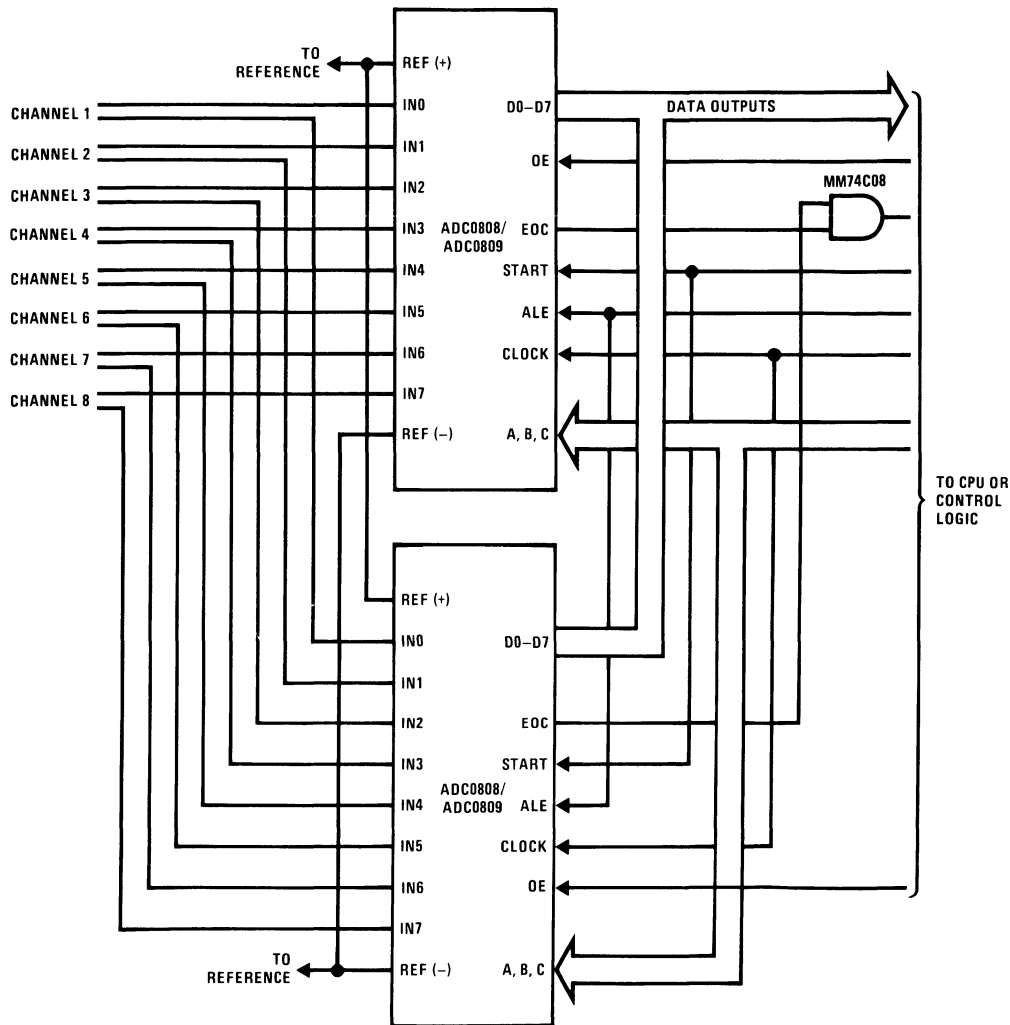


FIGURE 10. Dual Converter Differential Circuit

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2.4 Analog Input Considerations

Analog inputs into the ADC0808/ADC0809 can handle any input signal that is maintained within the supply limits, but some careful consideration must be given to the output im-

pedance of the transducer or buffer. Using transducers with large source impedances can cause errors due to comparator input currents.

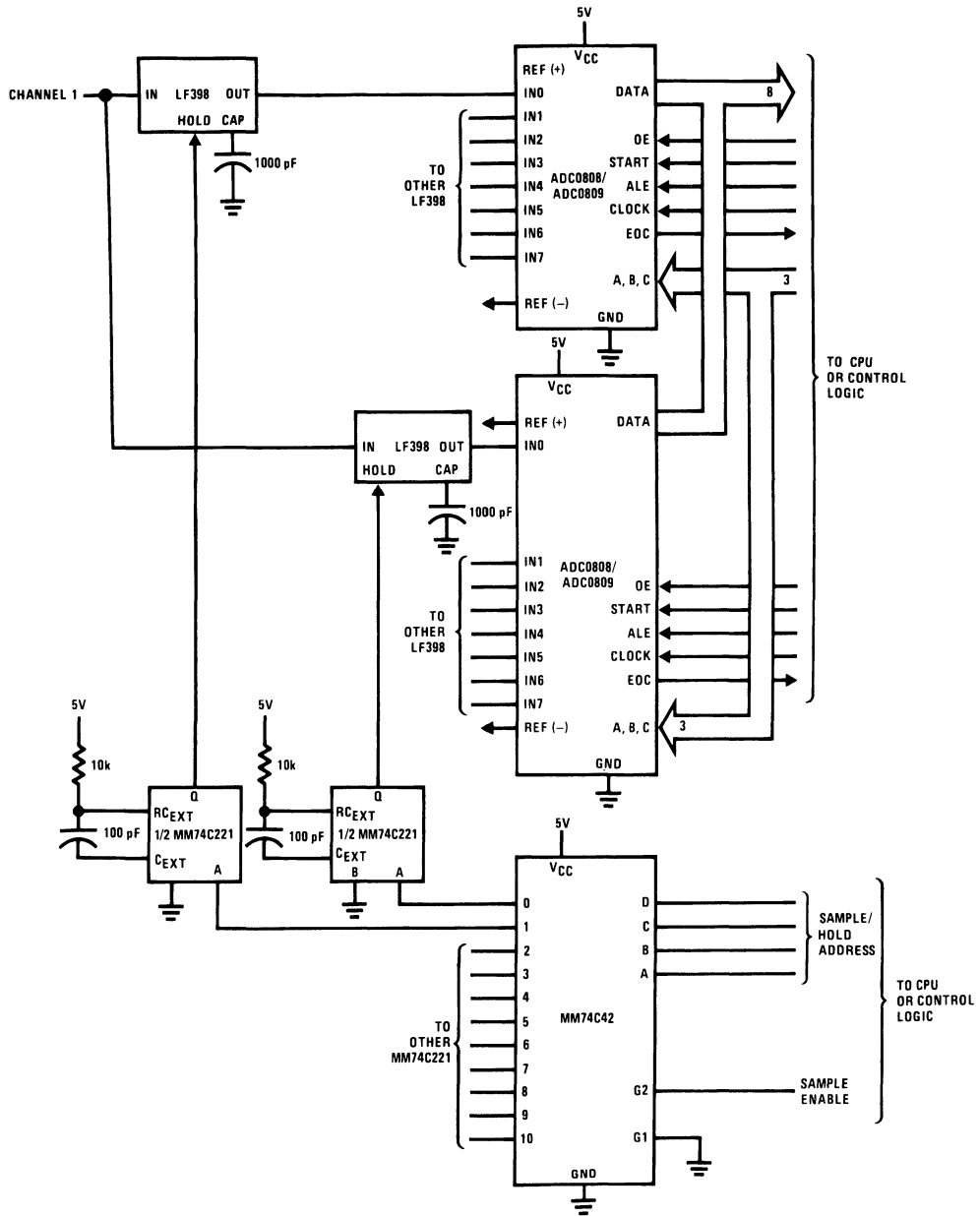


FIGURE 11. Parallel Data Acquisition with Sample/Holds

TL/H/5623-7

To understand the nature of these currents a short discussion of comparator operation is required. *Figure 12* shows a simplified model of the comparator and multiplexer. This comparator alternately samples the input voltage and the ladder voltage. As it samples the input, C_C and C_P are charged up to the input voltage. It then samples the ladder and discharges the capacitor. The net charge difference is determined by a modified inverter chain and results in a 1 or 0 state at the output.

Eight samples are made per conversion, resulting in eight spikes of varying magnitude on the input.

If the source resistance is large, it adds to the RC time constant of the switched capacitor which will inhibit the input from settling properly, causing errors. As one might expect, the maximum source resistance allowable for accurate conversions is inversely proportional to clock frequency. This resistance should be $\leq 1 \text{ k}\Omega$ at 1.2 MHz and $\leq 2 \text{ k}\Omega$ at 640 kHz. If a potentiometer-type ratiometric transducer is used it should be $\leq 5 \text{ k}\Omega$ at 1.2 MHz and $\leq 10 \text{ k}\Omega$ at 640 kHz.

If large source impedances are unavoidable ($\geq 2 \text{ k}\Omega$ at 640 kHz), the transient errors can be reduced by placing a bypass capacitor $\geq 0.1 \mu\text{F}$ from the analog inputs to ground. This will reduce the spikes to a small average current which will cause some error as well, but this can be much less than the error otherwise incurred. The maximum voltage error for a potentiometer input with a bypass capacitor added is:

$$V_{\text{ERR}} \approx \left[\frac{R_{\text{POT}}}{5} (I_{\text{IN}}) \frac{C_{\text{k}}}{640 \text{ kHz}} \right] \text{V}$$

where R_{POT} = total potentiometer resistance; I_{IN} = maximum input current at 640 kHz, 2 μA ; and C_{k} = clock frequency.

For standard buffer source impedance the maximum error is:

$$V_{\text{ERR}} = \left[I_{\text{IN}} R_{\text{S}} \left(\frac{C_{\text{k}}}{640 \text{ kHz}} \right) \right] \text{V}$$

where R_{S} = buffer source resistance; I_{IN} = the maximum input current at 640 kHz, 2 μA ; and C_{k} = clock frequency.

3.0 MICROPROCESSOR INTERFACING

The ADC0808/ADC0809 converters were designed to interface to most standard microprocessors with very little external logic, but there are a few general requirements which must be considered to ensure proper converter operation. Most microprocessors are designed to be TTL compatible and, due to speed and drive requirements, incorporate

many TTL circuits. The data outputs of the ADC0808/ADC0809 are capable of driving one standard TTL load which is adequate for most small systems, but for larger systems extra buffering may be necessary. The EOC output is not quite as powerful as the data outputs, but normally it is not busbed like the data outputs.

The converter inputs are standard CMOS compatible inputs. When TTL outputs are connected to any of the digital inputs a pull-up resistor should be tied from the TTL output to V_{CC} , $\sim 5 \text{ k}\Omega$. This will ensure that the TTL will pull-up above 3.5V.

Usually the converter clock will be derived from the microprocessor system clock. Some slower microprocessor clocks can be used directly, but at worst a few divider stages may be necessary to divide microprocessor clock frequencies above 1.2 MHz to a usable value.

The timing of the START and ALE pulses relative to channel selection and signal stability can be critical. The simplest approach to microprocessor interfaces usually ties START and ALE together. When these lines are strobed the address is strobed into the address register and the conversion is started. The propagation delay from ALE to comparator input of the selected input signal is about $\sim 3.0 \mu\text{s}$ (input source resistance $< < 1 \text{ k}\Omega$). If the start pulse is very short the comparator can sample the analog input before it is stable. When using a slow clock $\leq 500 \text{ kHz}$ the sample period of the comparator input is long enough to allow this delay to settle out.

If the ADC0808/ADC0809 clock is $> 500 \text{ kHz}$, a delay between the START and ALE pulses is required. There are three basic methods to accomplish this. The first possibility is to design the microprocessor interface so that the START and ALE inputs are separately accessible. This is simple if some extra address decoding is available. Separate accessibility of the START and ALE pins allows the microprocessor, via software, to set the delay time between the START and ALE pulses.

If extra decoding is not available, then START and ALE could be tied together. To obtain the proper delay, the microprocessor would cause START/ALE to be strobed twice by executing the load and start instruction twice. The first time this instruction is executed, the new channel address is loaded and the conversion is started. The second execution of this instruction will reload the same channel address and restart the conversion. But since the multiplexer address register contents are unchanged the selected analog input will have already settled by the time the second instruction is issued. Actual implementations of these ideas are shown in following sections.

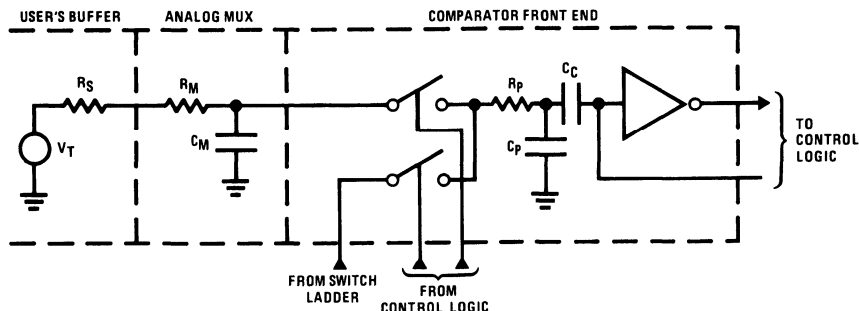


FIGURE 12. Analog Multiplexer and Comparator Input Model

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A third possibility when ALE and START are tied together is to stretch the microprocessor derived ALE/START pulse by inserting a one-shot at these inputs and creating a positive pulse $>3 \mu\text{s}$. Since ALE loads the multiplexer register on the positive going edge of the pulse and START begins the conversion on the falling edge, the width of the pulse sets the ALE to START delay time.

Most microprocessor interfaces would be designed such that a START pulse is issued by a memory or I/O write instruction, although a memory or I/O read can be used. The ALE strobe on the other hand, requires a write by the CPU when A, B, and C are connected to the data bus, and could use a read instruction if A, B, and C are connected to the address bus, but the software could get confusing. The logic to derive the OE strobe must be connected to the microprocessor so that a memory or I/O read instruction will cause OE to be pulsed. A read is required since the

ADC0808/ADC0809 data must be read.

3.1 Interfacing to the 8080

The simplest interface would contain no address decoding, which may seem unreasonable; but if the system ports are I/O mapped, up to 8 of them can be connected to the CPU with no decoding. Each of the 8 I/O address lines would serve as a simple port enable line which would be gated with read and write strobes to select a particular port. This scheme is shown in *Figure 13*. A7 is the address line used and, whenever it is zero and an I/O read or write is low, the port is accessed. This implementation shows A, B, C connected to D0, D1, D2 causing the information on the data bus to select the channel, but A, B, and C could be connected to the address bus, with a loss of only 3 ports. Both decoding schemes are tabulated in *Figure 14*. (Remember A, B, C inputs are only valid when selecting a channel to convert, and are not used to read data.)

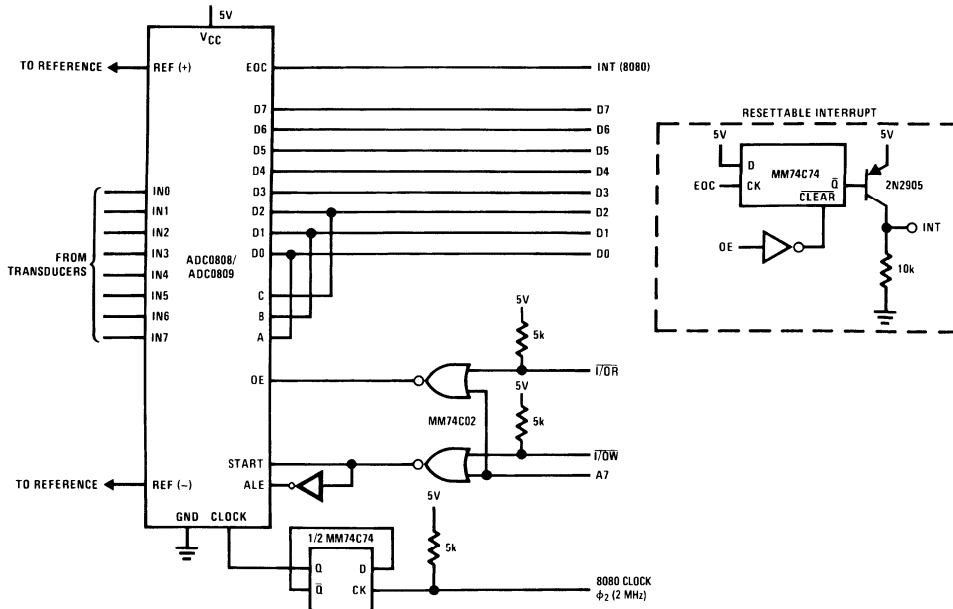


FIGURE 13. Minimum 8080/8224/8228 Interface

TL/H/5623-9

A7	A6	A5	A4	A3	A2	A1	A0	D2	D1	D0	Output Port Description
1	1	1	1	1	1	1	0	X	X	X	Spare Port
1	1	1	1	1	1	0	1	X	X	X	Spare Port
1	1	1	1	1	0	1	1	X	X	X	Spare Port
1	1	1	1	0	1	1	1	X	X	X	Spare Port
1	1	1	0	1	1	1	1	X	X	X	Spare Port
1	1	0	1	1	1	1	1	X	X	X	Spare Port
1	0	1	1	1	1	1	1	X	X	X	Spare Port
0	1	1	1	1	1	1	1	0	0	0	Channel 0 Port
0	1	1	1	1	1	1	1	0	0	1	Channel 1 Port
0	1	1	1	1	1	1	1	0	1	0	Channel 2 Port
0	1	1	1	1	1	1	1	0	1	1	Channel 3 Port
0	1	1	1	1	1	1	1	0	1	1	Channel 4 Port
0	1	1	1	1	1	1	1	1	0	0	Channel 5 Port
0	1	1	1	1	1	1	1	1	0	1	Channel 6 Port
0	1	1	1	1	1	1	1	1	1	0	Channel 7 Port

FIGURE 14a. Write Address Decoding for 8080 Output Ports (A, B, C Connected to D0, D1, D2)

A7	A6	A5	A4	A3	A2	A1	A0	Output Port Description
0	1	1	1	1	0	0	0	Channel 0 Port
0	1	1	1	1	0	0	1	Channel 1 Port
0	1	1	1	1	0	1	0	Channel 2 Port
0	1	1	1	1	0	1	1	Channel 3 Port
0	1	1	1	1	1	0	0	Channel 4 Port
0	1	1	1	1	1	0	1	Channel 5 Port
0	1	1	1	1	1	1	0	Channel 6 Port
0	1	1	1	1	1	1	1	Channel 7 Port
1	1	1	1	0	X	X	X	Spare Port
1	1	1	0	1	X	X	X	Spare Port
1	1	0	1	1	X	X	X	Spare Port
1	0	1	1	1	X	X	X	Spare Port

X = don't care

FIGURE 14b. Modified Write Address Decoding for 8080 Output Ports (A, B, C Connected to A0, A1, A2)

Two LSTTL NOR gates are used to generate the ADC0808/ADC0809 read/write strobes. When the 8080 writes to the ADC0808/ADC0809 the ALE and START inputs are strobed, loading and starting the conversion. When the CPU reads the ADC0808/ADC0809 the OE input is taken high, and the data outputs are enabled.

Figure 13 implements a simple interrupt concept where EOC is tied directly to the 8080 interrupt input. When the INS8228 is used and the INTA pin is tied high through a 1 kΩ resistor, the interrupt will cause a restart, RST, instruction to be executed, which will then cause a jump to a restart vector and execution of the interrupt routine. If a very simple multi-interrupt system is desired, a wire OR'ed configuration employing resettable latches as shown in Figure 13's inset can be used. In this simple design the MM74C74 is reset when the ADC0808/ADC0809 data is read. If more complicated interrupt structures are required, then an interrupt controller is usually the best solution.

The I/O port address structure for Figure 13's implementation is shown in Figure 14a. If the A, B, C inputs are tied to A0, A1, A2 inputs the port structure is as shown in Figure 14b. The later method makes each channel look like a separate port address, whereas if A, B, C are tied to the data bus the ADC0808/ADC0809 looks like one start conversion port address which is selected by the 3-bit status word written to it on the data bus.

Figure 15 shows a slightly more complex interface, where the address is partially decoded by a DM74LS139, dual 2-4 line decoder which creates the read and write strobes to operate the converter. This design interfaces to the processor in a polled type of interface. An MM80C97 TRI-STATE buffer is used to buffer the EOC line to the data bus, as well as provide the correct level for the START, ALE, and OE pulses. The converter clock is a divided 8080 system clock.

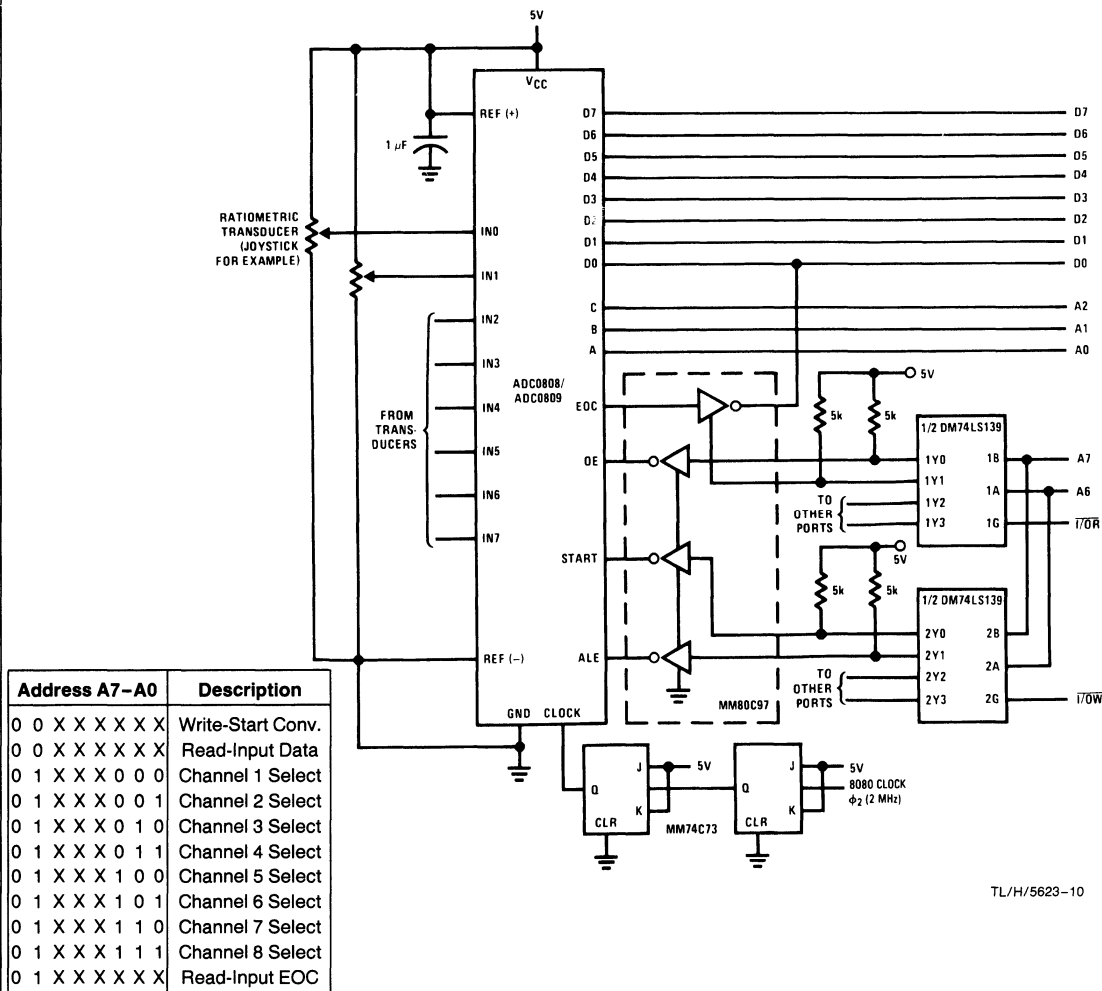


FIGURE 15. 8080/8224/8228 Interface Using Partial Decoding

Typically, the software to use *Figure 15* would first select the desired channel by writing the channel address to the ALE port address, 01XXXCBA, where X=don't care, and CBA is the channel address. Next the conversion is started by writing to the START address, 00XXXXXX. Now the processor must wait a few instruction cycles to allow EOC to fall. Once EOC falls, its status can be checked by reading the EOC line, address 01XXXXXX. When the EOC line is detected high again (a low on DO), the data can be read by accessing the OE port, address 00XXXXXX. As in the previous example the A, B, C inputs can be tied to D0, D1, D2 rather

than A0, A1, A2, so that the information on the data bus selects the channel to be converted. *Figure 15* can be connected in an interrupt mode by incorporating the interrupt flip-flop of *Figure 13*.

A few typical utility routines to operate the ADC0808/ADC0809 application in *Figure 13* are shown in *Figure 16a*. These routines assume that the resettable interrupt flip-flop is used. *Figure 16b* illustrates some typical polled I/O routines for *Figure 15*. Notice that in *Figure 16a* the OUT START1 instruction is executed twice to allow the analog input signal to settle as discussed earlier.

```

;
;
; START CONVERSION (A, B, C CONNECTED TO D0, D1, D2)
;
CHANN1          EQU      7
START1          EQU      7FH
DATA            EQU      7FH
;
START:          LDA      CHANN1      ; LOAD CHANNEL ADDRESS INTO ACE
                OUT      START1      ; STORE IT TO ADC0808/ADC0809 AND START
                OUT      START1      ; RESTART ADC0808/ADC0809 TO ACCOUNT FOR
;                                     ; MULTIPLEXER DELAY
                EI              ; ENABLE INTERRUPTS IF NOT ALREADY
                —          —        ; PROCESS PROGRAM
;
; INTERRUPT HANDLER ROUTINE
;
INTRP:          IN       DATA       ; READ DATA AND RESET INTERRUPT
                —          —        ; PROCESS DATA
                EI              ; ENABLE INTERRUPTS IF DESIRED
                RET           ; RETURN TO MAIN PROGRAM

```

FIGURE 16a. Typical 8080 Resettable Interrupt I/O Routines

```

;
; START CONVERSION (A, B, C CONNECTED TO A0, A2, A3) AND POLL EOC
; (FIGURE 15)
SELECT          EQU      40H      ; SELECT CHANNEL 0
START           EQU      00H      ; START CONVERTER
EOCIN          EQU      40H      ; READ EOC
DATA           EQU      00H      ; READ DATA
START:          OUT      SELECT     ; SELECT CHANNEL
                OUT      START     ; START CONVERSION
                NOP              ; INSERT INSTRUCTIONS TO WAIT 0-8
                NOP              ; CLOCK PERIODS OF ADC0808/ADC0809 CLOCK
                NOP              ; FOR EOC TO DROP (8NOPs MINIMUM)
                NOP
;
; READ AND TEST EOC
;
STATUS:         IN       EOCIN     ; INPUT EOC BIT
                ANI      01H      ; MASK OUT OTHER BITS
                JZ       READY     ; IF INPUT BIT IS ZERO JUMP READY
                —          —        ; ELSE CONTINUE EXECUTING PROGRAM
; OR
; CONTINUOUS POLLING ROUTINE
;
STAT 2:         IN       EOCIN     ; INPUT EOC STATUS BIT
                ANI      01H      ; MASK OUT ALL BITS BUT DO
                JNZ      STAT 2    ; JUMP TO TRY AGAIN IF NOT READY
READY:          IN       DATA     ; IF READY INPUT DATA
                —          —        ; CONTINUE EXECUTING PROGRAM

```

FIGURE 16b. Typical Polled I/O Routines for ADC0808/ADC0809

The application in *Figure 17* uses a 6-bit bus comparator and a few gates to decode a read and write strobe. Viewed from the CPU this interface looks like a bidirectional data port whose address is set by the logic levels on the T_n inputs of the DM8131 comparator. When data is written to the ADC0808/ADC0809 the 3 least significant bits on the address bus define the channel to be converted. The rest of the bits are decoded to provide the START and ALE strobes. When the conversion is completed EOC sets the interrupt flip-flop, and when the data is read the interrupt is reset.

Both the decoder and the bus comparator methods of address decoding have their own advantages. Bus comparators will more completely decode addresses but are capable of only a limited number of port strobes. Decoders, on the other hand, provide less decoding but more port strobes. There is a trade off for minimum parts systems as far as which route to go, and it will depend on the CPU and type of system.

3.2 Interfacing to the 6800

The ADC0808/ADC0809 easily interface to more than one microprocessor. The 6800 can also be used to control the converter. The 6800 has no separate I/O address space so all I/O transfers must be memory mapped. In general more address decoding logic is required to ensure that the I/O ports don't overlap existing memory. For small systems a partial address decoding scheme is shown in *Figure 18*. Generally, if several ports are desired, a small block of

memory would be set aside, as is accomplished by the DM8131. *Figure 18* also illustrates a typical 6800 interrupt scheme using a flip-flop and open collector transistor. The interrupt is reset when the data is read. If more ports are needed, a decoder could be added as shown in *Figure 19*. *Figure 19* also illustrates a polled I/O mode using TRI-STATE buffer to gate EOC onto the data bus. As with the INS8080 the A, B, C inputs of the ADC0808/ADC0809 can be connected to the address bus or the data bus.

The 6800 differs from the INS8080 in that the 6800 has a single read/write (R/W) strobe and a valid memory address (VMA), whereas the INS8080 has separate read and write strobes ($I\overline{O}R$ and $I\overline{O}W$). Normally, to obtain a read pulse, VMA, R/W and ϕ_2 are gated together and, for a write R/W is inverted. ϕ_2 is the 6800 phase 2 system clock. Also notice that the 6800 INT interrupt input is active low. This enables a standard wired-OR open collector design to be implemented.

Figure 20 illustrates some typical 6800 software utility routines for either polled or interrupt interfaces. Again notice double start instructions.

3.3 Z80 Interface

Interfacing the Z80 to the ADC0808 is much the same as interfacing to an 8080/8224/8228 CPU group. CPU instruction timing is very similar, except the read/write control signals are slightly different. Instead of the $I\overline{O}W$ write strobe there is the $I\overline{O}REQ$ and \overline{WR} and instead of $I\overline{O}R$, $I\overline{O}REQ$ and \overline{RD} are supplied.

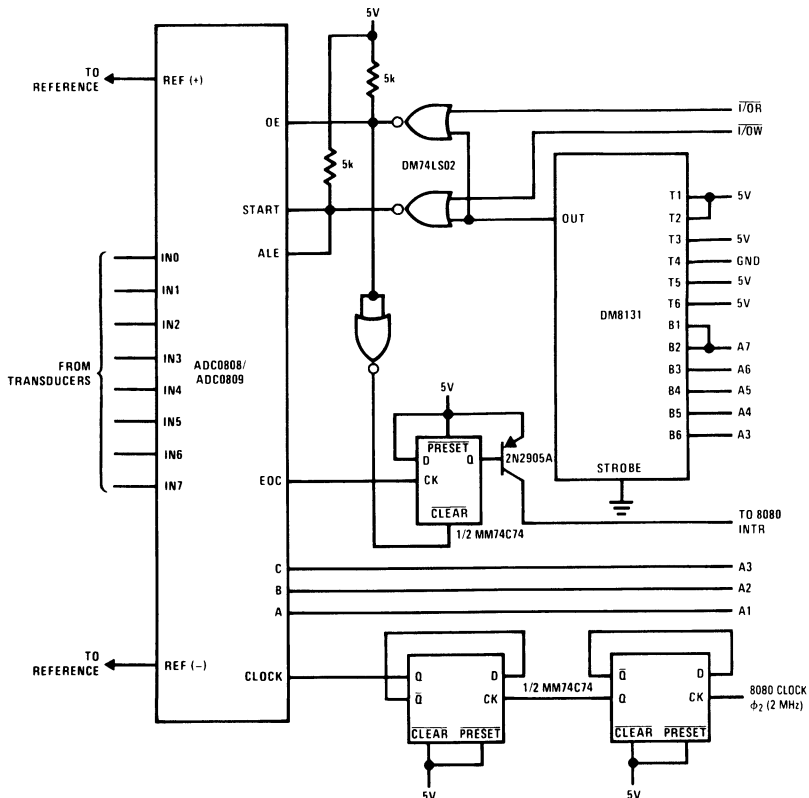


FIGURE 17. Interrupt-Type 8080/8224/8228 Interface Using 6-Bit Bus Comparator

TL/H/5623-11

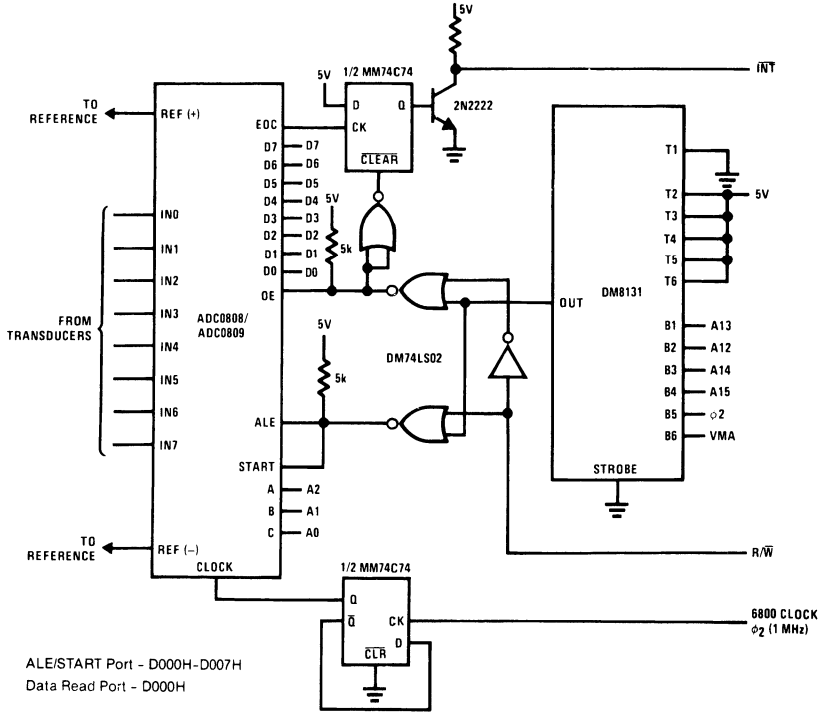


FIGURE 18. Typical 6800 Interface with Partial Address Decoding

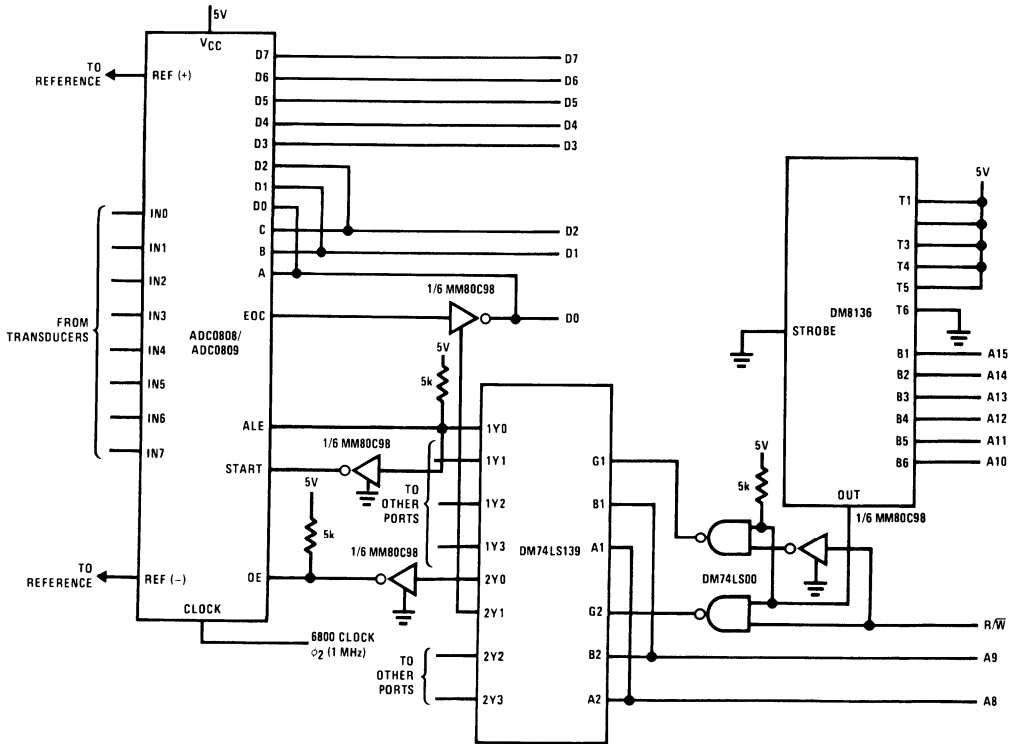


FIGURE 19. Full Decoded 6800 Interface Address


```

*
*UTILITY ROUTINES FOR ADC0808/ADC0809 INTERFACE
*
*
*LOAD AND START CONVERSION (FIGURE 18)
*
STATUS      EQU      $D800      START ADDRESS FOR CHANNEL 0
DATA        EQU      $D800      CONVERTER DATA ADDRESS
*
*
*
START       STA      STATUS      SELECT CHANNEL 0 AND START
           STA      STATUS      DO AGAIN TO LET INPUTS SETTLE
           LDX      #VECTOR     LOAD INTERRUPT VECTOR ADDRESS
           STX      $FFF8      STORE IT
           ---
           ---
           ---
           CLI
           ---
           WAI                  ENABLE INTERRUPT IF NOT ALREADY
                                EXECUTE MISC PROGRAM
                                WAIT FOR INTERRUPT
*
*INTERRUPT HANDLER (FIGURE 18)
*
VECTOR      LDAA     DATA      LOAD DATA RESET INTERRUPT
           CLI
           ---
           RTI                  ENABLE INTERRUPTS (OPTION)
                                EXECUTE PROGRAM
                                RETURN TO MAIN PROGRAM
*
*START AND TEST CONVERSION POLLED MODE (FIGURE 19)
*
DATA2       EQU      $F800      CONVERTER DATA ADDRESS
CHANN2      EQU      02        CHANNEL 2 ADDRESS
EOCIN       EQU      $F900      EOC INPUT PORT
START2      LDAA     CHANN2     LOAD A ACCUMULATOR
           STAA     STATUS     LOAD ADDRESS AND START
           NOP
           STAA     STATUS     WAIT
           NOP              RESTART TO LET MUX SETTLE
           ---            8 NOPS TO WAIT FOR EOC
           ---            TO GO LOW
           LDAA     EOCIN      LOAD EOC STATUS BIT
           ANDA     01        MASK BITS 1-7
           BEQ     READY      IF A = 0 THEN CONVERTER DONE
*
*
*
           ---
           EXECUTE MISC PROGRAM
*
*CONTINUOUS POLLING OF EOC (FIGURE 19)
*
*
POLLIT      LDAA     EOCIN      LOAD EOC STATUS
           ANDA     CHANN2     MASK MSBs
           BNE     POLL IT     IT ACC≠0 NOT READY, LOOP
READY LDAA     DATA      ELSE READ DATA
           ---
           ---
           CONTINUE PROGRAM

```

FIGURE 20. Typical I/O Routines for ADC0808/ADC0809 and 6800 Interface

Figure 21 shows a very simple Z80 interface, which is similar to the INS8080 interface of Figure 13, except that the interrupt flip-flop design is closer to the 6800 designs. This is because the Z80 \overline{INT} is active low as is the 6800, but the INS8080 INT is active high.

Figure 22 shows a fully decoded bus comparator design where the DM8131 decodes 5 address bits and the \overline{IOREQ} I/O request strobe. Two NOR gates gate the \overline{RD} and \overline{WR} strobes for ALE, START and OE inputs.

4.0 CONCLUSION

Both the ADC0808 and the ADC0809 can be easily used in microprocessor controlled environments. Many sophisticated medium throughput applications can be handled with a minimum of extra hardware, but additional hardware can increase flexibility and simplify software. Putting both the multiplexer and A/D on the same chip frees the designer from matching multiplexers and A/Ds to implement a 7 or 8-bit accurate system. Design time and overall system cost can be reduced by using these low cost converters.

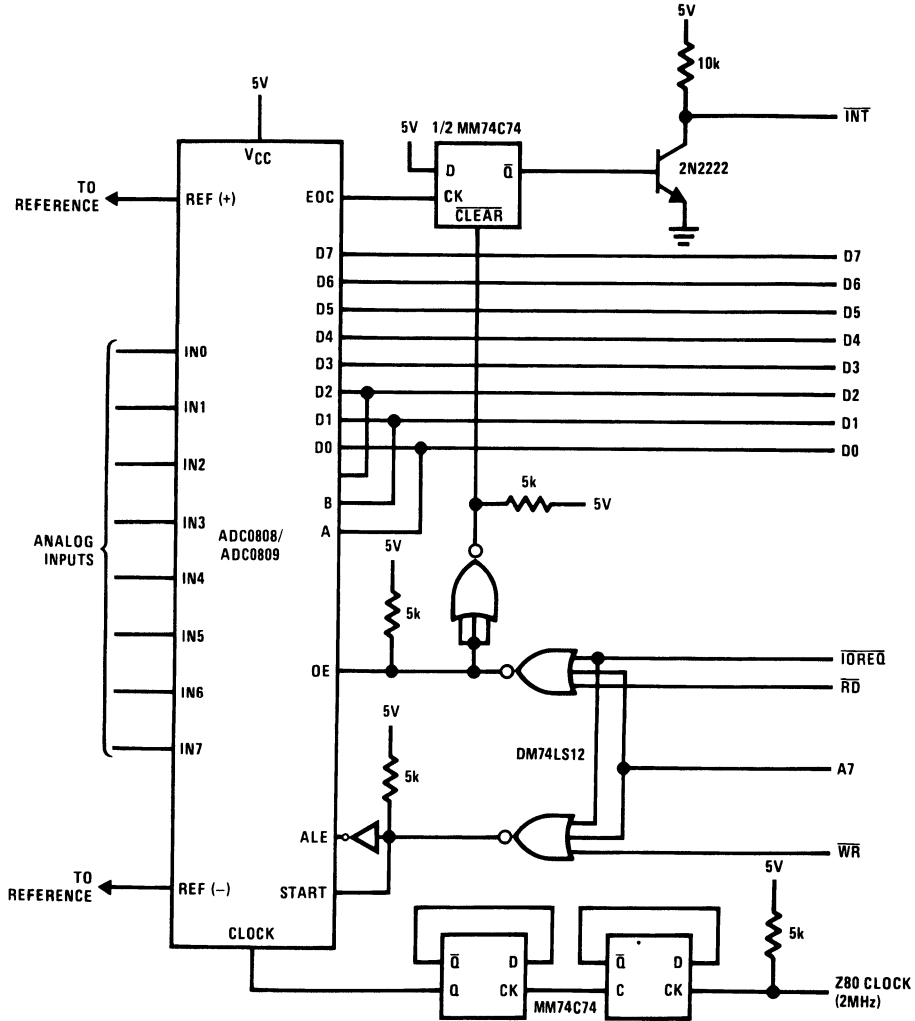


FIGURE 21. Simple Z80 Interface

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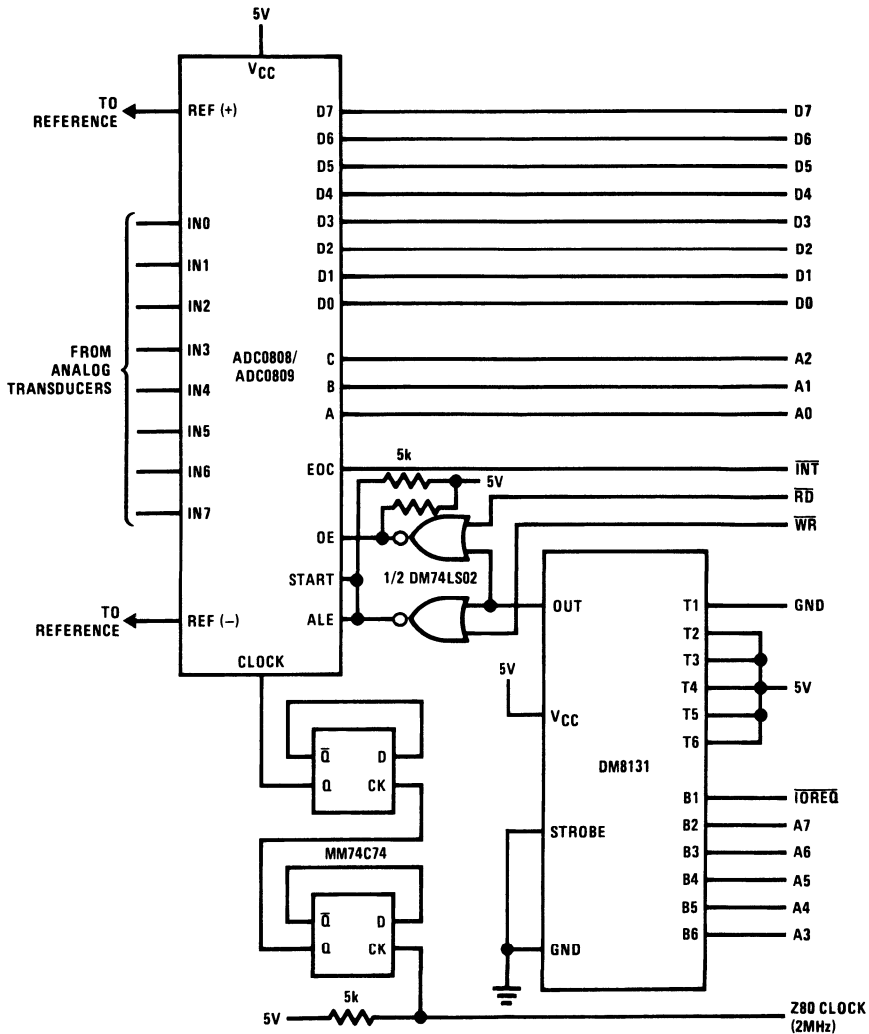


FIGURE 22. Z80 Partial Decoding Interface

TL/H/5623-14

Speech Synthesis

National Semiconductor
Application Note 252
Jim Smith
Dave Weinrich



INTRODUCTION

Electronic speech circuits offer a new dimension of sophistication to many modern machines. As annunciators in trains, elevators, office buildings, autos, airplanes, terminals, toys and games, etc., electronic speech circuits provide a more direct and natural announcement than bells, buzzers or lights. With electronic voice signals, complex directions can be clearly given in any language and with a minimum of effort.

In the past, electronic announcement systems required elaborate tape mechanisms. These systems were expensive and troublesome, so their use was limited to the small number of applications that required speech announcements (e.g., telephone announcement systems). The first all-electronic systems used analog to digital conversion techniques to convert actual voice into digital signals. These digital speech signals were then stored as PCM or delta modulation signals in semiconductor memories. The major problem with this arrangement was the massive memory required for a moderate amount of announcement time. One second of digital speech, in this configuration, required from 16k to 100k bits of memory.

The latest solution to electronic speech is known as speech synthesis. This technique provides a dramatic reduction in the memory required for one second of speech. Memory requirements range from 400 bits to 2000 bits per second depending on the desired speech attributes and overall quality. The synthesizer techniques takes advantage of the fact that speech signals are highly redundant and predictable. By coding only the slowly varying coefficients of speech or by dramatic compression of digitized speech, significant bandwidth reductions in the digitized signal can be realized. These techniques, coupled with LSI semiconductor technology, make true voice synthesis practical.

The National Semiconductor speech processor chip (SPC) provides the complete speech synthesis reproduction circuitry needed to generate high quality and natural speech (male, female or a child's voice), electronic tones or music. A complete chip set is called the Digitalker®. It consists of the speech processor chip and a speech ROM. The applications for this chip set are endless, but to name a few:

- Voice interactive computer terminals

- Automotive, nautical and aeronautical instrumentation annunciators

- Voice-back units for banking, weather and time announcements, answering machines, etc.

- Elevators, trains, subway systems, etc.

- Consumer appliances, toys and games

- Warning systems for fire and police emergency

All of these applications benefit from the lower overall costs, high reliability, excellent performance and fast control response afforded by the National Semiconductor Digitalker system. The remainder of this note will be

devoted to a description of the MM54104 SPC, the technique used to synthesize speech and finally a review of the major Digitalker applications.

SPEECH SYNTHESIS

The basic phonological element of speech is the phoneme. The phoneme represents a simple sound that by itself cannot distinguish different words. Phonemes, together with speaker inflection, volume, emphasis, etc. are the fundamental building blocks of speech. The overall quality of any speech synthesizer, therefore, is directly controlled by its ability to faithfully reproduce all of the necessary speech attributes and not just phoneme reproduction.

The common American English language consists of approximately 38 to 40 phonemes—14–16 vowel sounds and 24 consonant sounds. Each phoneme is generated with either a voiced sound, as in "eye", or an unvoiced sound like the sh in "shy". This difference between a voiced and unvoiced sound is very important because the unvoiced sounds are generally fewer in number and less dependent upon the physiological characteristics of the speaker. A speech synthesizer, it turns out, can exploit this important difference. Finally, normal speech rates are approximately 10 to 15 phonemes per second (including silence intervals). Since 38–40 phonemes can be coded using 6 bits, the normal bit rate for phoneme reproduction is approximately 60 to 90 bits per second. This bit rate, however, contains only phoneme information which is only one of the many important speech attributes.

Since phoneme reproduction is a basic element in any speech synthesizer, an understanding of phoneme construction would be useful. Speech synthesis models use two driving functions, an impulse source for voiced sounds and a noise source (hiss noise) for unvoiced sounds. Each of these driving signals are filtered into specific frequency bands or formants by time-varying filters. The net result, for any particular set of valid filter coefficients, is a formant sound. In the human vocal tract system, the driving function consists of the lungs as the energy source, and the vocal cords for generating a voiced sound. The driving function for an unvoiced sound relies on the noise generated as air rushes through the vocal chambers and not on vocal cord vibrations. The formants are then generated by the resonant chambers of the throat, mouth and nasal cavities. By controlling the physical nature of these chambers with mouth position, tongue position and throat orifice size, a speaker can control the formants to generate a phoneme. It should be noted, however, that formants are identified by distinctive frequency bands. The unvoiced sounds do not generate these distinctive bands and therefore do not necessarily require the "normal" formants for a faithful reproduction. These sounds are characterized by a noise or hiss with very little resonance. This unvoiced resonance is normally identified as a fricative formant (e.g., the "sh" sound) and is characterized by an unusually large content of high frequencies.

A formant-based speech synthesizer, as described previously, would normally use at least three formant filters for voiced sounds and one formant filter for fricative sounds. An additional resonance, called nasal resonance, may be included but no dynamic formant function is usually associated with the nasal resonator. For the synthesis of a normal English vowel using a male voice, the three basic formants would fall into the approximate frequency bands of 200 Hz to 800 Hz, 900 Hz to 2300 Hz and 2400 Hz to 3000 Hz. The fricative formant is typically a pulse of high frequency noise in the band from approximately 2500 Hz to 8000 Hz, with the higher frequency fricatives like "th" usually much lower in relative amplitude when compared to the "sh" fricative sound.

The basic formant synthesizer requires formant filter coefficient data, amplitude control data and driving function control data. This minimum system could synthesize speech, but would not control inflection or emphasis. Its quality, therefore, can be very disappointing. Normal memory requirements for a minimal system are approximately 400 bits for one second of speech.

A second approach to speech synthesis does not automatically break speech into its minimum phonological elements. Instead, the speech waveform is sampled, digitized and compressed by the elimination of symmetrical redundancy and silent intervals, the use of adaptive delta modulation, and the adjustment of phase information in the digitized speech. In this way, speech elements can be synthesized as phonemes, phoneme groups, words or even whole phrases. Also, the attributes of the original speaker can be maintained if the synthesized elements are not broken down incorrectly (i.e., inflection can modify the sound of a phoneme if it occurs at the end of a word or phrase rather than at the beginning).

In a speech compression system, unvoiced sounds can be standardized. During the compression algorithm, the voiced and unvoiced sounds are separated and the voiced sounds are compressed. Unvoiced sounds, however, are compared to the available sounds and synthesized by substitution. This approach is successful because unvoiced sounds have very few speaker defined characteristics. As a result, a relatively small set of unvoiced sounds can be used repeatedly.

This speech compression technique offers excellent quality at a low data rate. The synthesis of a male voice, using English, will usually require an average of 1000 bits per word. Because the technique can be applied to any voice frequency signal, it is also capable of synthesizing women's and children's voices, music and tones. This flexibility, plus the realistic quality of the synthesized speech, make this technique very attractive.

THE NSC SPEECH PROCESSOR CHIP (SPC)

The National Semiconductor speech synthesis system consists of the SPC device plus the speech memory (ROM) required to assemble a complete Digitalker kit. To this kit a customer must add a clock input signal or the necessary oscillator components, an audio filter and amplifier and the control circuit function. This would represent the minimum configuration shown in *Figure 1*. The maximum amount of directly addressable speech memory accessible by the SPC is 128k bits, but external page addressing by the control circuit function can increase this ROM field as required.

The SPC utilizes the speech compression synthesis technique. As mentioned earlier, this technique reduces the amount of memory needed to store electronic speech by removing the excess or redundant data from the speech

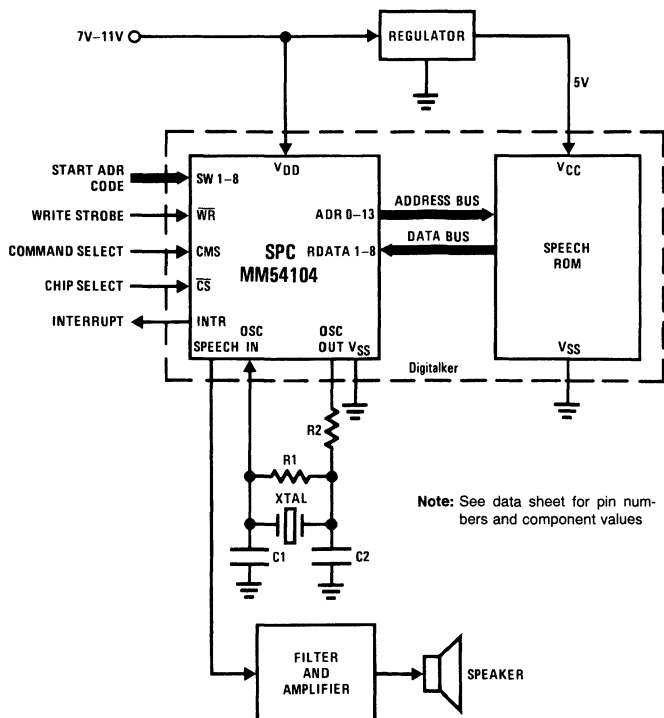


FIGURE 1. Digitalker Minimum Configuration

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signal. The four main techniques to perform that task are:

1. Elimination of redundant pitch periods
2. Adaptive delta modulation coding to minimize bandwidth and memory requirements
3. Phase angle adjustments to create mirror image symmetry
4. Replacing the low level portion of a pitch period with silence (half-period zeroing)

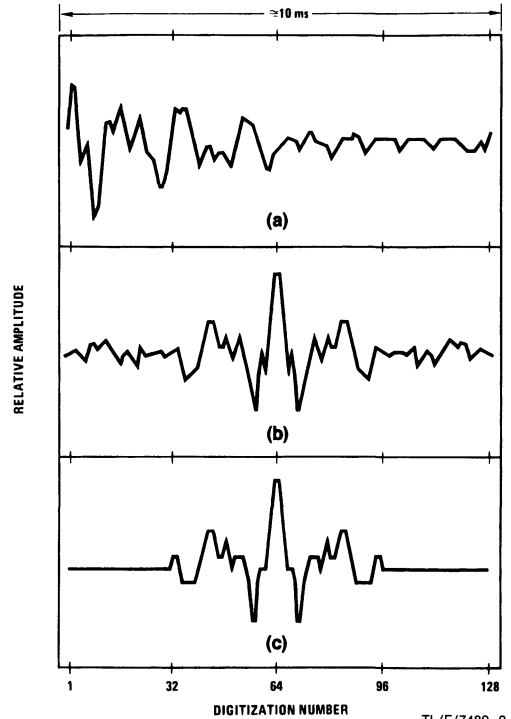
National Semiconductor uses an elaborate computer program to analyze a high fidelity tape recording and generate a ROM pattern that will faithfully synthesize the original voice message.

Figure 2 contains a block diagram of the MM54104 SPC. The eight-bit start address bus allows up to 256 separately defined sounds or expressions to be stored in the speech ROM. The control interface to the start address port can take the form of decoding logic, a MICROBUST™ port or mechanical switches.

When the \overline{WR} goes high, the start address code is loaded into the control word address register. The SPC uses this control address to fetch the control word from ROM for the first block of speech data. The control word contains waveform information, repeat information and the address of the speech data. This address is loaded into the phoneme address register and is used to fetch the speech data used to recreate the speech waveform. Before the synthesis takes place, the waveform data must be decoded to provide information such as male or female, voiced or unvoiced, half-period zeroed or not half-period zeroed and silence.

The unsynthesized waveform for a typical voiced pitch period might look like the signal shown in Figure 3a. In the process of converting this signal to a synthetic form, several operations are performed. First, the phase delay of the signal can be adjusted to create a symmetrical waveform about the center of the pitch period as shown in Figure 3b. The next step will replace the low level beginning and ending quarters of the waveform with silence (Figure 3c). The result is a compression factor of 4 to 1 on the original voice data. Now, delta modulation is applied and the results are

shown in Figure 3c. Synthesis of the waveform starts with a period of silence (no speech data required), a quarter period of adaptive delta modulation-generated speech followed by



(a) Original Speech Waveform
 (b) Phase Angle Adjusted to Create Mirror Symmetry
 (c) Half-Period Zeroed and Delta Modulated

FIGURE 3. SPC Waveforms (After Mozer [2])

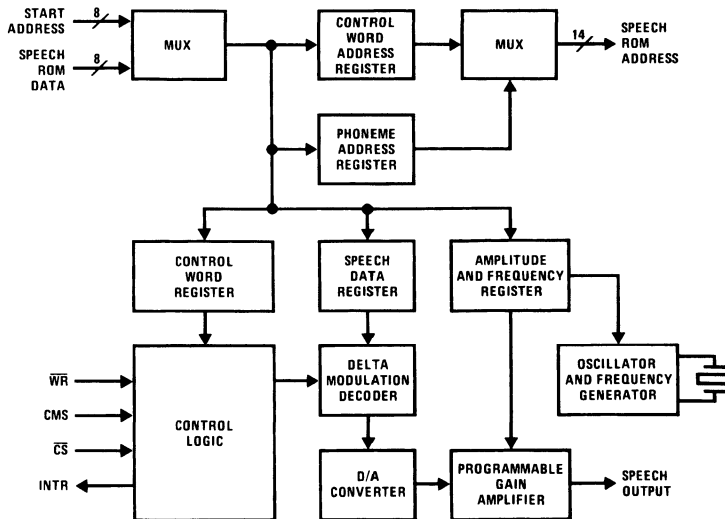


FIGURE 2. MM54104 Block Diagram

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the same speech data fetched in reverse. Finally, the SPC will finish the last quarter cycle of the speech block period with silence. This phase modified speech data sounds the same as the original speech.

At the end of a waveform or speech block, the SPC makes a decision about repeating the sequence. Each waveform of a typical voiced signal may be repeated an average of 3 to 4 times. The typical unvoiced waveform may be repeated approximately 7 to 8 times. Once the proper number of repeats has been generated, the SPC will begin a new speech block sequence. This operation continues until the SPC has executed all control words associated with the original eight-bit start address code.

SPC speech signals are stored as adaptive delta modulation data. This encoding technique exploits the relatively predictable and slowly changing characteristic of voiced speech. Because of the small differential between successive speech samples, a delta value rather than an absolute value can be used to determine the actual speech signal. Addition of the delta value to previously accumulated values will result in a new output waveform signal level. An adaptive technique is used so that the delta step size can change in response to slope variations. This technique uses multiple delta modulation step sizes to obtain a more accurate resolution and yet, the required amount of stored data remains lower than the information required for a more conventional encoding scheme.

The internal SPC clock is derived from a programmable frequency generator. Variations in the frequency of this clock, through the control word, allow the SPC to add a rising and falling pitch to speech sounds and syllables. This derived pitch variation adds a natural inflection to the synthetic speech.

Just as pitch variations are used to increase realism, so must the SPC use gain variations. Both techniques are controlled by data stored at the beginning of a speech block and the programmable oscillator and output amplifier circuit blocks of the SPC.

Use of the Digitalker is quite straightforward and will be outlined in the next section. However, a point on application that must be covered in this note concerns the frequency response of the output speech. The ultimate quality of the Digitalker will strongly depend upon the filter, amplifier and speaker choices made by the user. For that reason, it is important to understand the output characteristics of the device.

Because the synthesized speech data is derived from a differentiated and sampled input signal, it is necessary to pass the output waveform of the MM54104 through a low-pass filter with a cutoff frequency of approximately 200 Hz and an attenuation characteristic of 20 dB/decade. This compensates for the high frequency pre-emphasis used in the synthesis technique. If the system of interest has a natural roll-off near 200 Hz, this low-pass filter can be eliminated. The important item is that the entire audio system should have a cutoff frequency of approximately 200 Hz. The placement of the cutoff frequency may be adjusted for the particular type of voice being synthesized. A low pitched man's voice might sound better with a 100 Hz cutoff point while women's and children's voices may show improvements with a 300 Hz cutoff. *Figure 4a* shows a filter and amplifier circuit for this minimum frequency response characteristic.

As an example of how the overall frequency response of a particular application can minimize the need for extra filtering, consider the Digitalker as a voice announcement circuit in a telephone system.

In this case, the telephone network provides a natural attenuation to high frequencies that balances the SPC high frequency pre-emphasis. As a result, the low-pass filter previously mentioned can be eliminated. However, because signal frequencies above 3 kHz must be attenuated before they are allowed to pass into the telephone network, a cutoff filter of 3400 Hz may be required in place of the previously mentioned 200 Hz low-pass filter. A good filter for this application is the National Semiconductor AF133 active filter.

In addition to the 200 Hz to 3400 Hz low-pass filter, an extra stage of filtering can be used for frequencies above 7 kHz. This filter is optional and is normally only used to further reduce sampling noise. Most systems can omit this filter, especially if the overall system bandwidth is not very wide. A second optional filter can be included to limit the overall low frequency response of the system. This high-pass filter would normally cutoff below 200 Hz (adjusted to match the 200 Hz low-pass if provided). This high-pass filter limits low frequency noise, and can usually be omitted if system characteristics do not require this function. A circuit having the full frequency response characteristic is shown in *Figure 4b*. *Figure 5* shows the recommended overall speech synthesis system frequency response.

APPLICATIONS

While the variety of synthetic speech applications are numerous, the actual implementation in any single application is usually limited to one of the following three techniques.

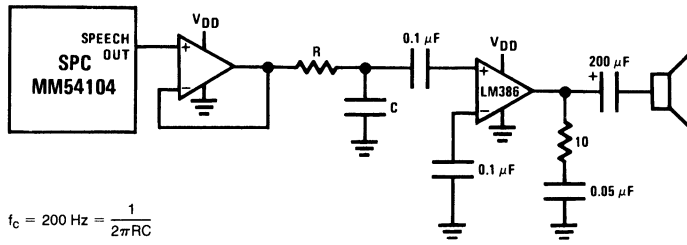
- (a) Single channel, hardware control logic
- (b) Single channel, software control logic
- (c) Multichannel, hardware or software control logic

Each of these circuit approaches for the SPC will be discussed in this section. Particular emphasis will be placed on items (b) and (c), however, because of the broad application possibilities for these two techniques.

Certain applications require a relatively small number of sentences or announcements with very little similarity between the different sentences. An example of this application might be a talking elevator controller where the messages are brief and non-redundant (e.g., "going up, first floor, second floor", etc.). In this application, certain words are used repeatedly but the number of messages is limited and the length of each message is short. This application and others just like it, do not require the assembly of short phrases into complete sentences, nor do they require a dynamic message structure as would be required with an automatic bank teller (e.g., "your change is ten dollars") where a monetary amount may change from message to message. This fixed message application, therefore, may only require the minimum control circuit as shown in *Figure 6*.

In *Figure 6*, the SPC receives a separate coded input for each complete sentence or message that is synthesized. This input code is received by the SPC through the SW 1-8 port.

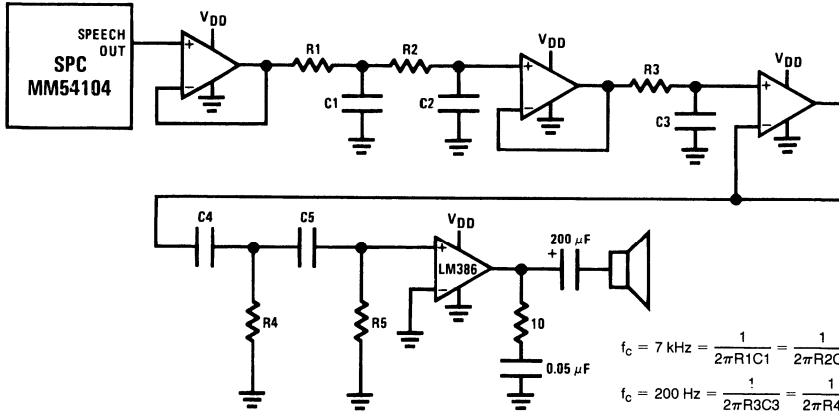
The circuit shown in *Figure 6* uses a mechanical switch group to interface the SPC while the *Figure 7* circuit uses a hardware logic controller to input the coded message control data.



$$f_c = 200 \text{ Hz} = \frac{1}{2\pi RC}$$

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(a) Minimum Low-Pass Filter/Amplifier



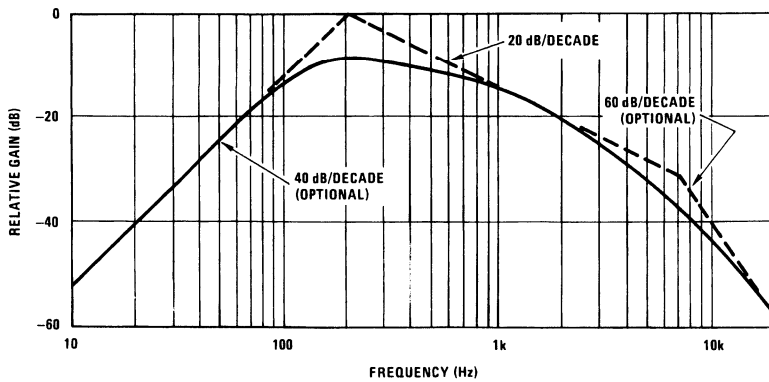
$$f_c = 7 \text{ kHz} = \frac{1}{2\pi R1C1} = \frac{1}{2\pi R2C2}$$

$$f_c = 200 \text{ Hz} = \frac{1}{2\pi R3C3} = \frac{1}{2\pi R4C4} = \frac{1}{2\pi R5C5}$$

TL/F/7480-5

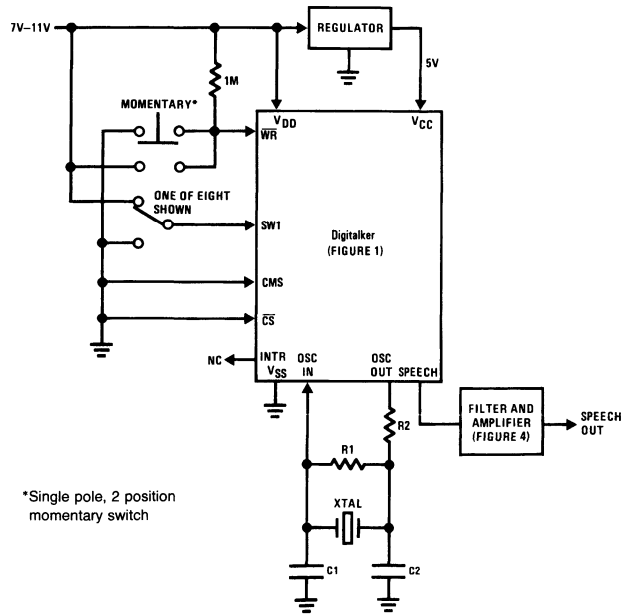
(b) Maximum Filter Response Configuration

FIGURE 4. SPC Filter and Amplifier



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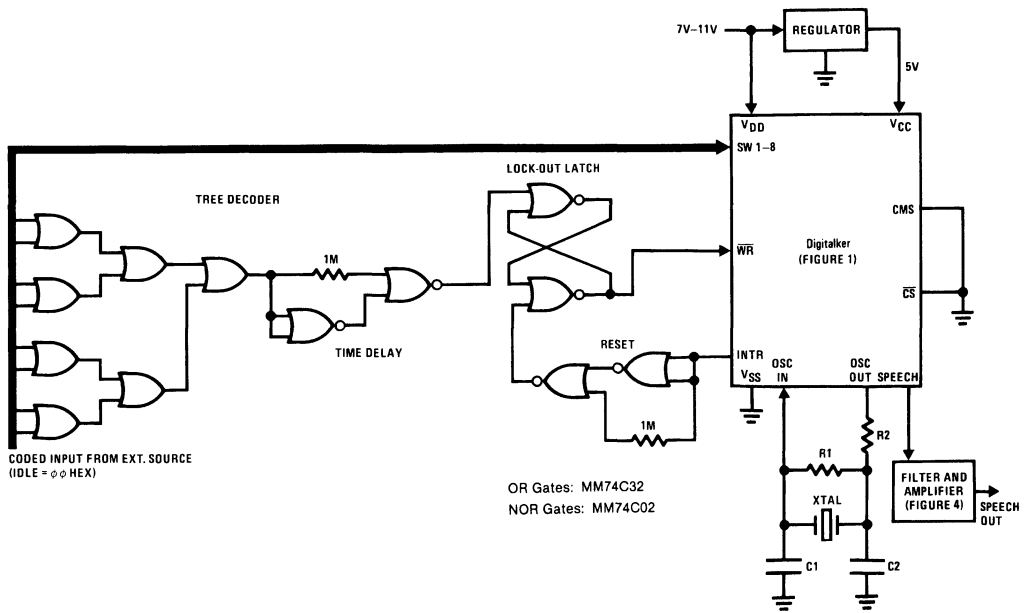
FIGURE 5. Recommended Frequency Response of Entire Audio System for MM54104 SPC



*Single pole, 2 position momentary switch

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FIGURE 6. Digitalker with Switch Interface



OR Gates: MM74C32
NOR Gates: MM74C02

TL/F/7480-8

FIGURE 7. Digitalker with Logic Control Interface

After the proper message address is established on the SW 1-8 port, a momentary pulse must be applied to the WR line. If this signal is applied with a momentary action switch, as shown in *Figure 6*, then an external pull-up resistor should be used to pull the WR line up to logic high and complete the on-chip switch debounce circuitry. The suggested value of this resistance is one megohm. The WR input signal will latch the coded message address into the SPC on the rising edge of WR and initiate the synthetic speech message. Since each complete message uses a unique address code of the SW 1-8 port, no further control action is required after this point. The SPC will synthesize the requested message and return to the idle state. If a new input command signal is received, either during or after a message is synthesized, the SPC will immediately abort the current message and begin the new one. The circuit in *Figure 7* shows a lock-out circuit to prevent the aborting of a current message so that messages must be completed before a new message can be initiated.

In *Figure 7*, a message is initiated whenever a valid code word is applied to the eight-bit SW 1-8 port of the SPC. The valid code is detected by the combinational logic decoder and timed to insure all transitions have died. Once the valid code is timed, an S-R latch is set and a WR rising

edge is generated to start the SPC. This latch circuit also prevents retriggering of the SPC until after the present speech message is completed. Once the synthesized message has ended, the SPC will set the INTR line to the logic one state and a reset pulse will be generated to reset the lock-out latch. A new speech message can now be started by momentarily applying an idle address code followed by a valid code on the SW 1-8 input port.

The SPC will directly address up to 128k bits of speech memory. *Figure 8a* shows a typical speech ROM configuration of 128k using two 64k ROMs. The types of ROMs used have mask programmable chip selects, therefore, no extra decode logic is required for memory requirements of less than 128k. Although this memory size is usually sufficient for most applications, certain systems may require added speech ROM addressing. The circuit in *Figure 8b* shows how the speech ROM of an SPC kit can be expanded in 128k bit pages or modules. Each page is arranged to contain a complete portion of the entire speech library for a particular system. Each single speech data block, as addressed via the start address port of the SPC, must be contained within one ROM page. No page boundaries can be crossed during the synthesis of a speech expression.

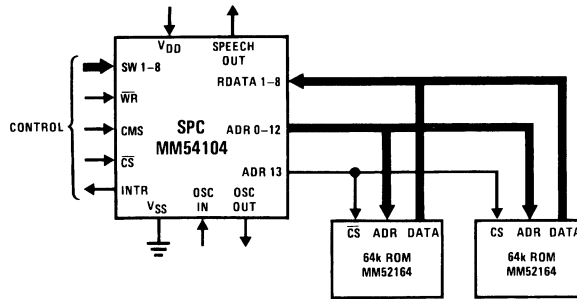


FIGURE 8a. Typical Speech ROM Configuration

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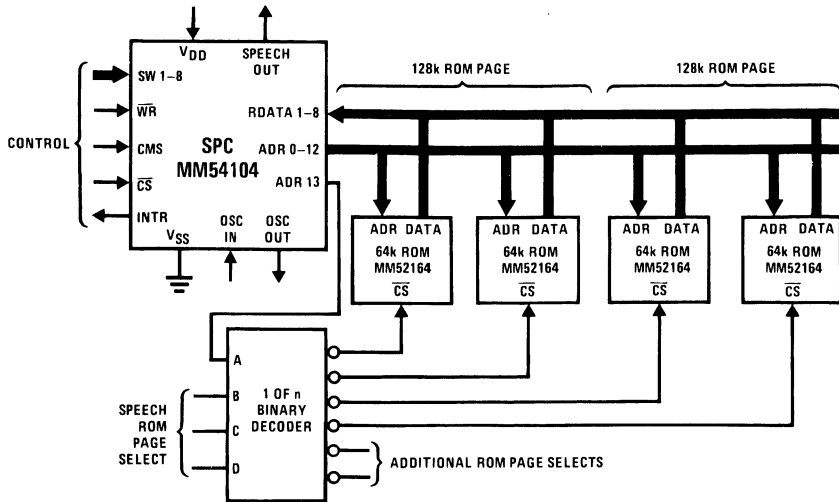


FIGURE 8b. Speech ROM Expansion Configuration

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While the simple control schemes discussed so far can be used in many applications, a far more important group of applications will take advantage of the SPC's ability to construct sentences from a group of words, sounds and phrases. This type of application uses an intelligent controller or a microprocessor to string together a group of synthesized phrases to form a complete sentence. The electronic bank teller, previously mentioned, is a good example of this application. The microprocessor controls the stringing of SPC code addresses and applies them, one at a time, to the SW 1-8 port of the SPC. Handshake timing between the microprocessor and the SPC is provided with the INTR line. This microprocessor interface arrangement is known as Microbus and the configuration is shown in *Figure 9*.

The use of a microprocessor controller expands the versatility of the SPC tremendously. Messages that are composed of numerical responses or fixed phrases in random sequence can be easily constructed from a library speech memory. In addition, various tones or warnings can be synthesized and added before, during, or after an announcement to identify the urgency of each message. For example, an automobile message may state that "oil pressure is low". Alone, that message may only mean that pressure has dropped but no immediate hazard exists. If, however, pressure has dropped below a critical value, the message could

be compounded to say "warning, oil pressure is low, pull over and stop the engine". In this latter case, phrases of high urgency are added to the initial message to increase its level of importance. Of course, the second message is not completely separate from the first but is, instead, an expansion of the first. This technique allows fewer input address codes to initiate a larger number of messages without assigning a separate address code for each message and for each of its derivatives. This would be particularly important to an electronic bank teller since a large number of monetary amounts must be synthesized for a relatively small number of finished sentences.

When preparing a speech ROM for an SPC that will synthesize whole sentences from groups of phrases, it is important to note the desired inflections. The SPC has the ability to synthesize all of the important speech attributes including pitch and gain variations, emphasis, inflection, etc. This leads to very high quality life-like synthetic speech if the stringing of phrases does not result in an artificial emphasis or inflection. It is important to choose phrases carefully and to record them with the attribute required for a realistic sentence string. The stringing of phonemes should be avoided whenever possible because the natural inflection is usually lost in such an arrangement.

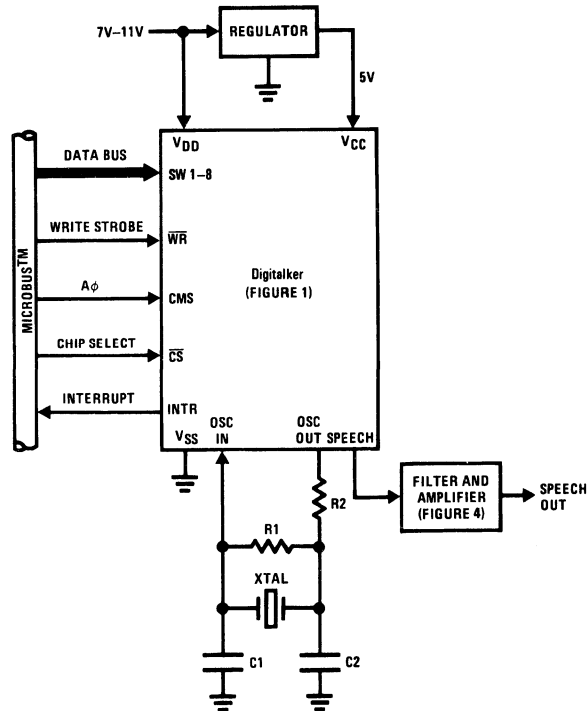


FIGURE 9. Digitalker with Microprocessor (Microbus) Interface

TL/F/7480-11

A low cost intelligent controller for the SPC is one of the COP400 series of microcontrollers. Figure 10 shows one possible arrangement of an SPC system and a COP420. The COP provides all of the advantages associated with a Microbus interface at a relatively low cost. Because of its limited I/O structure, the COP's serial I/O port is expanded as required to obtain the desired number of input lines.

The final application technique to be covered is the multi-channel configuration. The previous arrangements used an SPC and a dedicated set of speech ROMs to provide a single channel of synthetic speech. Appliances, autos, toys and games, terminals, etc. would probably use a single

channel SPC arrangement. But an entirely different group of products could take advantage of a multiple channel approach to reduce the ROM requirements. This group of products includes multiple elevator controllers, electronic bank tellers, multiple pupil learning centers, voice response telephone answering equipment, telephone switching system call announcement centers, etc. In this application, each channel would use a separate SPC and amplifier circuit, but several channels would share a common controller and speech library ROM. A typical configuration is shown in Figure 11.

The library ROM of Figure 11 is shared over eight SPC channels. Each SPC channel is scanned once in 16 μ s as

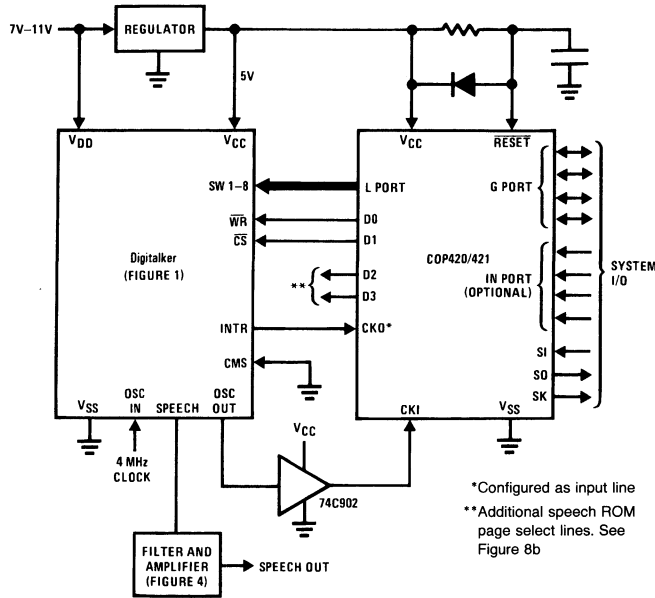


FIGURE 10. Digitalker with COP420/COP421 Interface

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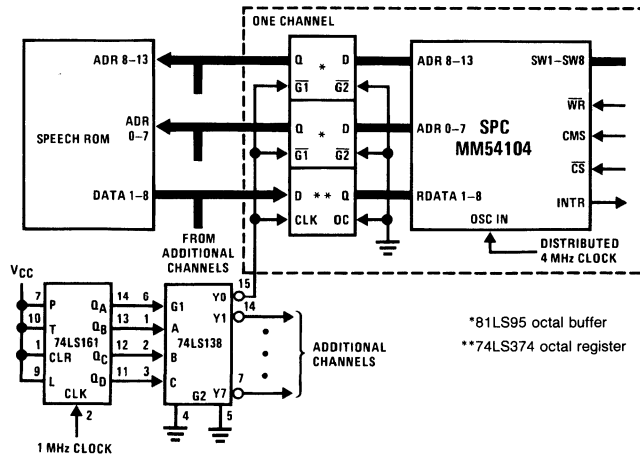


FIGURE 11. Multichannel Speech Synthesizer

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shown in *Figure 12*. During each channel period of $2 \mu\text{s}$, an SPC output address is presented to the ROM address input port via a pair of octal TRI-STATE® bus drivers. After one μs , the data from the ROM is clocked into the channel's octal data latch, the output of which is connected to the SPC ROM data input port. The remaining $1 \mu\text{s}$ of each channel cycle is provided for bus settling time.

When the speech library ROM is shared over many channels, the actual number of shared channels is controlled by the MM54104 SPC memory cycle timing. Because the channel scanning is asynchronous to the SPC cycle timing, it is necessary for each channel to be scanned at least once during the high interval of the $\overline{\text{ROMEN}}$ signal. As shown in *Figure 13*, this signal is high for at least $20 \mu\text{s}$ of each memory fetch cycle. Thus, a scanning rate of one channel every $16 \mu\text{s}$ will insure that each channel is scanned at least once while the $\overline{\text{ROMEN}}$ signal is high.

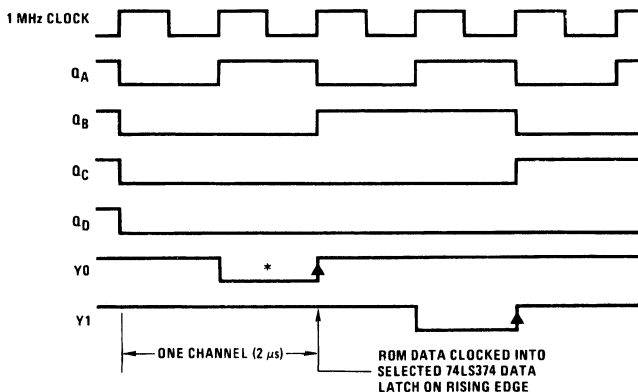
One final note is necessary about the configuration in *Figure 11*. Simple modifications to the counter and decoder circuitry would allow this circuit to handle sixteen channels. A four-line to sixteen-line decoder would replace the three to eight decoder and the clock would directly enable the decoder during the logic low clock period. All sixteen channels would be scanned every $16 \mu\text{s}$ and the scan interval for each

channel would be one μs —one-half μs of memory access time and one-half μs of bus guard time.

The last multichannel circuit is shown in *Figure 14*. This scheme reduces the number of wires needed between the speech ROM and each SPC channel. By multiplexing address and data over the same parallel bus, fewer wires are needed. This approach is particularly attractive when each SPC channel is located on an individual circuit card. A telephone central office or PABX announcement system is a typical example of a channel per card arrangement. *Figure 14* represents that type of system.

As shown in *Figure 15*, each channel of the unified bus approach is scanned for one μs . As many as sixteen channels, therefore, can be scanned during the $\overline{\text{ROMEN}}$ high cycle of any SPC. During each channel scan, the bus is gated to transmit the ROM address to latches on the ROM circuit board. The address is sent in two bytes. After a brief delay of one-half μs , the bus is gated to return the requested ROM data to the same SPC channel. This data is then latched on the SPC channel card. This scheme is very straightforward. It exchanges reduced interconnect wiring for additional logic circuits.

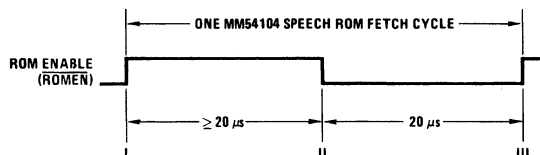
To minimize interconnect wiring when using a unified bus structure, the SPC control logic would probably be configured on a per channel basis. The COP microcontroller,



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*Note: Selected 81LS95 output enabled during this interval. Output is current ROM address code from SPC.

FIGURE 12. Multichannel Timing Diagram



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1. SPC about to output the next ROM address. Address will remain valid for remainder of the cycle.
2. Valid ROM data must be available to SPC shortly after this point.
3. Cycle ends, new cycle begins immediately.

FIGURE 13. MM54104 SPC Speech Memory Cycle Timing

once again, is a logical choice for this function. The COP controller initiates and assembles a group of fixed messages. Because of general similarities between the various messages, phrase strings are used to construct each finished message. Also, the circuit in Figure 14 allows one message to contain a non-fixed message—a telephone number. The COP controller reads a group of program switches or receives a down-loaded number from the switching systems's central processor. It then inserts this

number into the appropriate place during the synthesis of the following typical message—"The number you are calling has been changed. The new number is 555-3434". The ROM library in this case contains the phrases required for message construction and the data needed to synthesize the name of each decimal digit. The library could also contain the names of the teen digit pairs, and the words "hundred" and "thousand". These would be used to synthesize the words "thirteen hundred" or "two thousand", etc.

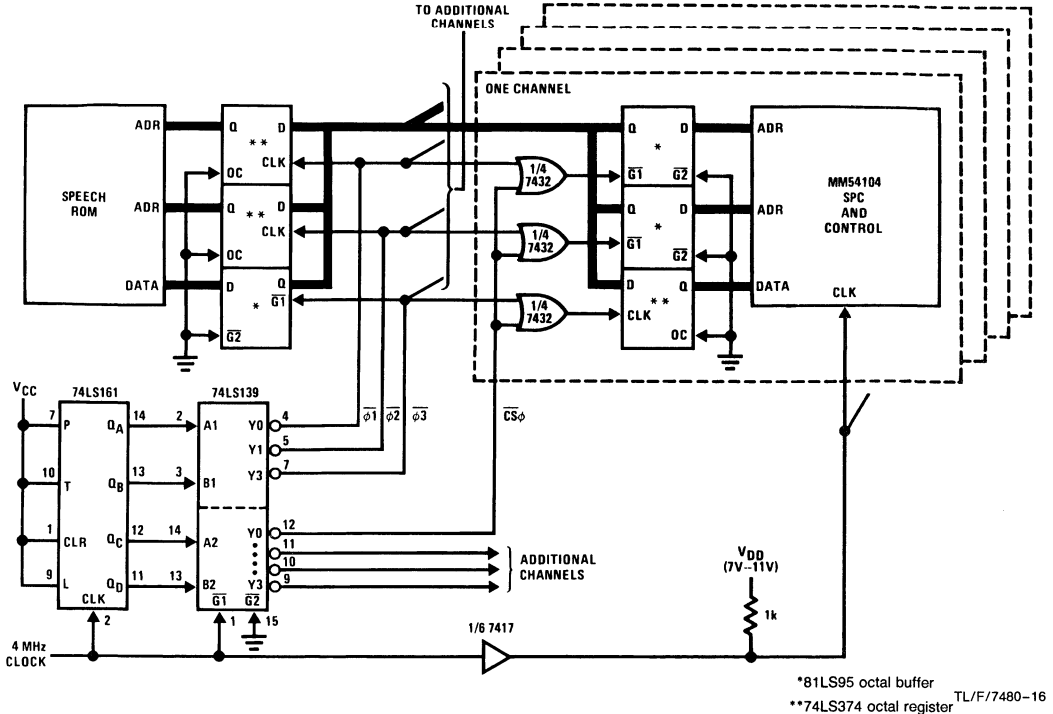


FIGURE 14. Multichannel Synthesizer with Unified Bus

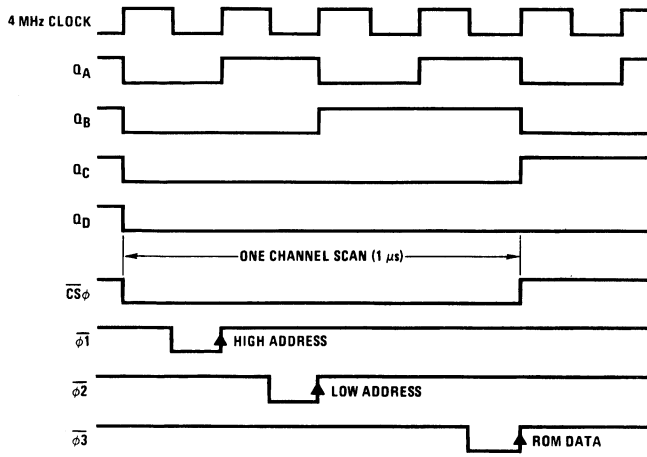


FIGURE 15. Multichannel (Unified Bus) Timing Diagram

SUMMARY

This application note describes some of the versatility and flexibility of the National Semiconductor Digitalker System. This system provides low cost speech and tone synthesis for products ranging from consumer items to computers. It provides a reliable alternative to mechanical systems (i.e. tape decks) without sacrificing voice quality. Also described in this note are a few of the most popular circuit arrangements possible with the Digitalker. Of particular interest are the methods outlined to assemble whole messages from phrase groups and the schemes used for multichannel synthesizer systems. This latter application is particularly interesting because of the memory savings for the multichannel user.

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1. Morris, Dennis E. and Weinrich, David W., *A New Speech Synthesis Chip Set*, IEEE International Conference on Acoustics, Speech and Signal Processing, 1980.
2. Mozer, Forrest, *Method and Apparatus for Speech Synthesis*, Pending US Patent.
3. Weinrich, David W., *A Speech Synthesis Chip Set Using Compression Techniques*, Electronics, April 10, 1980.

LH0024 and LH0032 High Speed Op Amp Applications

National Semiconductor
Application Note 253



INTRODUCTION

The LH0024 and LH0032 are very high speed general purpose operational amplifiers exhibiting 70 MHz bandwidths, 500 V/ μ s slew rates and 100 to 300 ns settling time to 0.1%. The LH0032 has the added advantage of FET input characteristics. Both, however, can drive loads with peak currents of 100 milliamperes (mA). The op amps are stable without external compensation when operating at closed-loop gains of more than 100. Both are constructed with thick film hybrid technology and are actively trimmed for consistent device performance. Table I summarizes the typical performance data for these op amps. Additional information may be obtained from the respective data sheets.

This note is divided into three parts, with the first giving a general description of the circuit topology of each op amp. In the following section, several high performance applications are discussed. Finally, the last section consolidates all application techniques into an integral design approach, much of which is applicable to any high frequency circuit.

LH0024 CIRCUIT DESCRIPTION

The LH0024 contains two gain stages: One is a differential NPN pair and the other is a single-ended PNP stage. The complete schematic is shown in Figure 1.

The input stage differential pair, Q8 and Q9, is biased at 6 mA by a current source made up of Q1, Q2, R3, and R5. First stage differential voltage gain is typically 2. Its output is applied differentially from base to emitter of the second stage transistor Q3 which has a gain of about 1,700. This stage also converts the differential signal to a single-ended output.

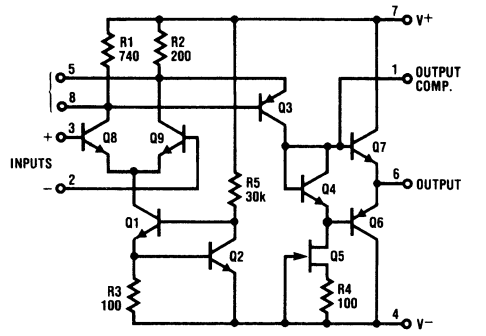
Current source Q5 and R4 provide 5 mA of DC bias current and a high impedance load to Q3. Overall amplifier gain is the product of the gains of the two stages— $2 \times 1700 = 3,400$, or 71 dB.

The output complementary pair with class B bias provides a low impedance sourcing and sinking output drive. Although the class B bias contributes a small amount of cross-over distortion, it is barely detectable in closed loop operation.

LH0032 CIRCUIT DESCRIPTION

The LH0032 is a general purpose operational amplifier similar to the LH0024, but with JFET input devices instead of bipolar. As a result, the LH0032 DC input bias and offset currents are three orders of magnitude lower than the LH0024. Its output drive capability is improved due to the use of a larger package with lower thermal resistance, and its class AB output, which is normally biased on, virtually eliminates cross-over distortion.

The improved DC performance is due, in part, to the incorporation of monolithic dual junction FETs in the input stage of the LH0032, providing matched DC tracking and good



TL/H/7313-1

FIGURE 1. Complete LH0024 Schematic Diagram

TABLE I. Typical Performance Characteristics

Parameter ($T_A = 25^\circ\text{C}$)	Conditions	LH0024	LH0032	Units
Input Offset Voltage		2	2	mV
Input Bias Current		15 μ A	10 pA	
Large Signal Voltage Gain	$V_{OUT} = \pm 10V$ $f = 1 \text{ kHz}, R_L = 1 \text{ k}\Omega$	71	70	dB
Slew Rate	$A_V = +1, \Delta V_{IN} = 20V$	500	500	V/ μ s
Small Signal Rise Time	$A_V = +1, \Delta V_{IN} = 1V$	8	8	ns
Settling Time to 1.0% of Final Value	$A_V = -1, \Delta V_{IN} = 20V$	80	100	ns
Settling Time to 0.1% of Final Value		275	300	ns
Unity Gain Bandwidth	(uncompensated)	70	70	Mhz

common-mode input characteristics. First stage operating current is set at 6 mA by the current source made up of transistors Q8 and Q9 and resistors R4 and R9, as shown in Figure 2. The first stage voltage gain is:

$$A_v (1st\ stage) = g_m R_L = 1.4 \quad (1)$$

Where: $g_m = 3.5\text{ mmho}$

$$R_L = R_1 \parallel (\beta_3 + 1) (r_{e3} + 2R_3)$$

The second stage consists of two identical pairs of differential PNP transistors in a cascode configuration. Each side operates at 5 mA set by the emitter resistor R3 and the bias of the first stage. The differential amplifier Q3 and Q4 feeds the common-base pair Q5 and Q6 with the base voltage fixed at $V^+ - 1.9$ volts by the diode string Q13-A15. Thus the collectors of the differential pair Q3 and Q4 are held at one V_{BE} drop more positive than the reference voltage. Any signal amplified by the differential stage produces only a very small change in Q3 and Q4 collector voltage. Consequently, the Miller effect on Q3 and Q4 (base-to-collector capacitances) is virtually eliminated. Using hybrid π model of the transistor, the voltage gain of the cascode stage may be approximated as:

$$A_v (2nd\ stage) = g_{m4} \times R_{eq} \approx 1,400 \quad (2)$$

$$\text{Where: } g_{m4} = \frac{5\text{ mA}}{0.026\text{ V}}$$

$$R_{eq} = \frac{1}{h_{ob6}} \parallel \frac{1}{h_{oe10}} \parallel (\beta_{11} + 1) (R_L)$$

Notice that the full differential gain is realized with the use of the current mirror Q10 and Q16, which also provides high active load resistance to the PNP cascoded pair, resulting in high amplifier gain.

The collector output of the cascode stage is buffered by a pair of complementary emitter follower transistors, Q11 and Q12. This class AB output stage is normally biased at 1 mA by the 1.8 V_{BE} voltage produced by Q7, R5, and R6. The emitter degeneration resistors provide protection from thermal runaway.

APPLICATIONS OF THE LH0024/LH0032

Applications of the high speed LH0024 and LH0032 range from video amplifiers to sampling circuits. The applications described below include high speed sample and hold circuits, photo-detector amplifiers, fast settling digital to analog converters and buffered amplifiers.

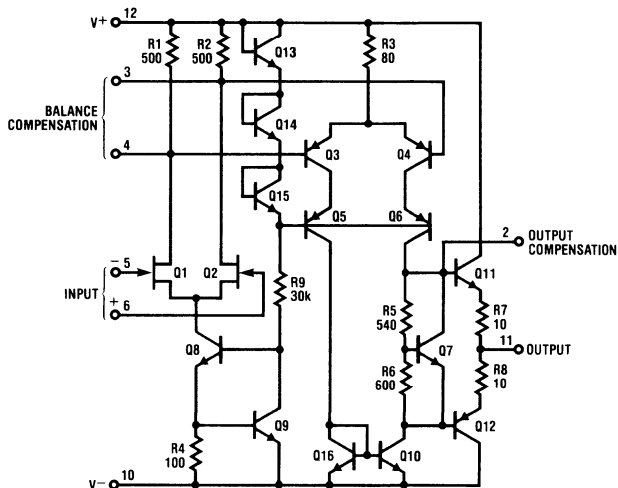


FIGURE 2. Complete LH0032 Schematic Diagram

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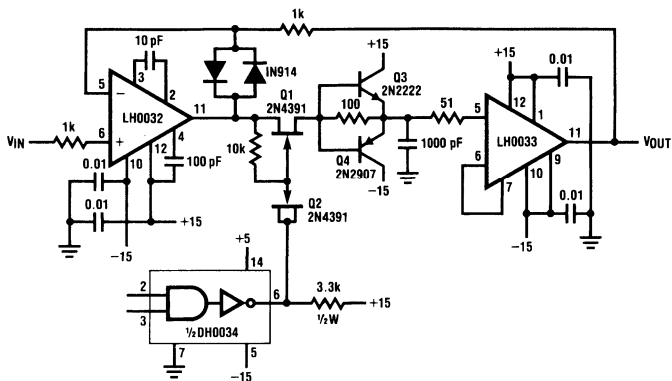


FIGURE 3. High Speed Sample and Hold Circuit

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A High Speed S/H Circuit

High Speed sample-and-hold circuits require high slew rate and fast settling amplifiers. The LH0032 is ideal for these applications. An example is shown in *Figure 3*.

The complementary emitter-follower Q3 and Q4 sources or sinks large peak current to rapidly charge or discharge the hold capacitor during step changes, thus effectively buffering the FET switch, Q1, whose $r_{D(ON)}$ would otherwise slow the charge time. The LH0033 FET-input amplifier buffers the output signal, providing 100 mA drive capability.

The circuit exhibits a 10V acquisition time of 900 ns to 0.1% accuracy and a droop rate of only 100 $\mu\text{V}/\text{ms}$ at 25°C ambient condition. An even faster acquisition time can be obtained using a smaller value hold-capacitor. By decreasing the value from 1000 pF to 220 pF, the acquisition time improves to 500 ns for a 10V step. However, droop rate increases to 500 $\mu\text{V}/\text{ms}$.

Fiber Optic Transmitter-Receiver Applications

Many fiber optic applications require analog drivers and receivers operating in the megahertz region where many so-called wide-band op amps simply run out of steam. Packed with 70 MHz gain-bandwidth product (unity gain compensated), the LH0032 is quite suitable for optical communication applications up to 3.5 MHz. *Figure 4* demonstrates a complete analog transmission system using this device.

The transmitter incorporates the LF356 to drive the light emitter. The LED is normally biased at 50 mA operating current. The input is capacitively coupled and ranges from 0V to 5V, modulating the LED current from 0 mA to

100 mA. The circuit can be easily modified to operate from a single +15V power supply. The only requirement is that the amplifier must be biased within the input common mode range.

The receiver circuit uses an LH0032 configured as a trans-impedance amplifier. A photodiode with 0.5 amp per watt responsiveness such as the Hewlett-Packard type HP5082-4220, generates 50 mV signal at the receiver output for 1 μW of light input.

Expectedly, the bandwidth of the entire optical link rests on the receiver circuit. Therefore, if the response time is to be optimized, one should reverse bias the photodiode to minimize junction capacitance. As a result, rise time improves more than 2 orders of magnitude. Next, the feedback resistor value should be chosen to be as large as possible in order to maximize sensitivity within the limits of allowable bandwidth degradation. Using 100 k Ω feedback resistor, the maximum system bandwidth is 3.5 MHz.

Fast Settling 12-BIT D/A Converter

A high resolution, fast-settling DAC can be constructed using the LH0032. Its low input bias current causes no significant DC error in conversion accuracy. Great care must be exercised in circuit layout to assure highest performance. A single point analog ground should be used with the digital ground separated. A complete circuit with 12-bit resolution is shown in *Figure 5*. The converter typically settles to 1/2 LSB in 800 ns for a 10V full-scale swing. Similarly, 10-bit or 8-bit resolution DACs may be constructed using the DAC1020 or DAC0808, respectively.

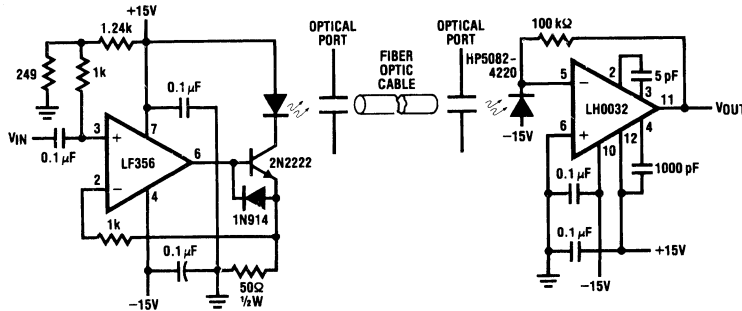


FIGURE 4. Fiber Optic Link

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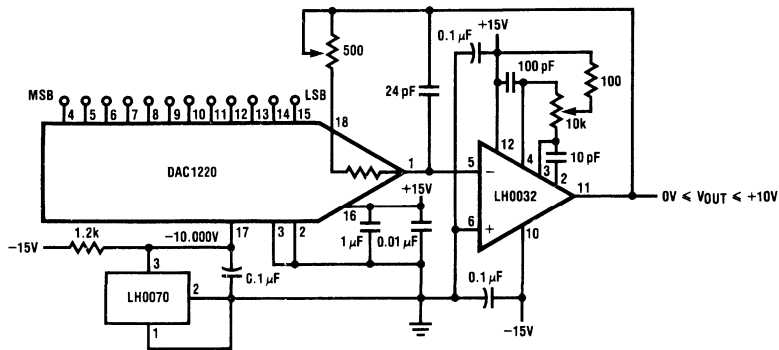
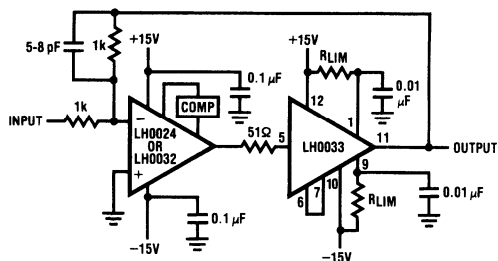


FIGURE 5. Fast Settling DAC

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Buffered Amplifier

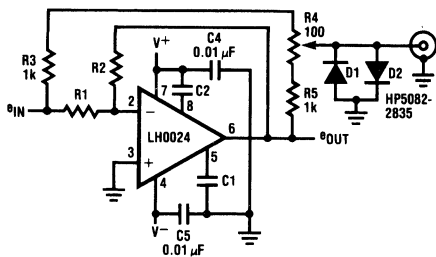
Whenever higher output current is required, a buffer amplifier may be added to the loop as shown in *Figure 6*. The LH0033 boosts the output drive capability to ± 100 mA continuous and ± 400 mA peak.



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FIGURE 6. Wide Band Amplifier with 100 mA Output Capability

Despite its 100 MHz bandwidth, the LH0033 introduces about 15 degrees of phase lag at the LH0032 unity-gain frequency of 70 MHz. As a result, phase margin is degraded by the same amount. Slight overcompensation may be required in order to restore adequate phase margin. One way is to increase the feedback capacitor from 5 pF to a slightly larger value, 6 to 8 pF should be sufficient. If the load is predominantly capacitive, the total phase shift of the buffer stage may exceed 180° and appear as negative impedance seen looking into the input of the buffer. The 51Ω resistor restores some real resistance to alleviate this condition and prevents potential oscillation. In cases where the load capacitance is relatively large, up to 100Ω may be necessary to compensate for it.



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DESIGN CONSIDERATIONS

Optimizing LH0024/32 Performance

The LH0024 and LH0032 allow considerable flexibility in designing high performance circuits if care is taken in the way they are used and implemented. Indeed, the printed circuit board layout in high frequency circuits is as important as the design of the hybrid devices themselves.

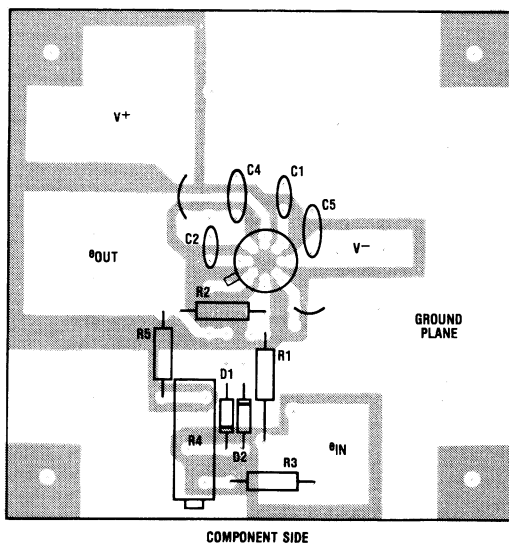
It is good practice to use ground plane PC board design. It provides a low resistance, low inductance path, and reduces stray signal coupling to sensitive circuitry. A double-sided ground plane is usually better and should be considered.

In addition, signal trace connections should be kept as short and wide as possible. Avoid closely-spaced parallel signal traces as signal cross-coupling may occur. Circuit elements should be placed close to the amplifier, particularly critical components that directly affect the amplifier's frequency response, such as compensation capacitors. If at all possible, one should maintain single point ground throughout the circuit to minimize signal phase delay.

Examples of single-sided PC layouts for the LH0024 and LH0032 are shown in *Figure 7* and *Figure 8*, respectively. The layouts include a settling time test circuit, optional inverting or noninverting mode. Note that the summing junction side of the feedback resistor is kept very close to the device pin, thus minimizing lead capacitance. The power supply decoupling capacitors should also be kept close to the device pins, preferably $\frac{3}{8}$ of an inch.

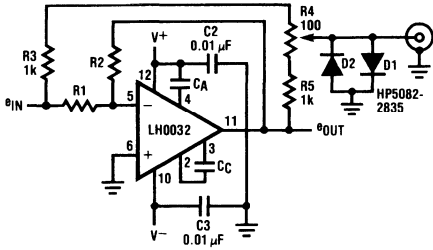
Input Guarding and Bootstrapping

In applications where input leakage currents are important, trace guarding, such as used in sample and hold circuits, can improve performance at no additional cost.

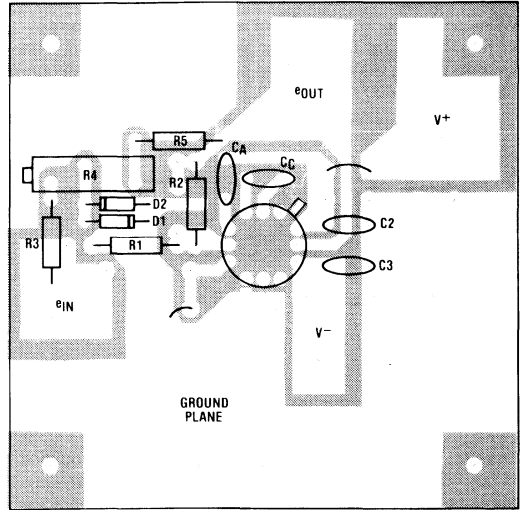


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FIGURE 7. Single-Sided Sample PC Layout for LH0024



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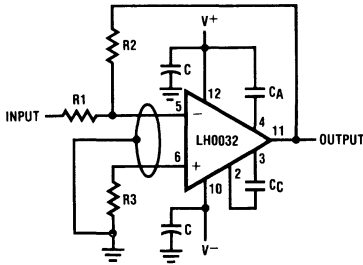
COMPONENT SIDE

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FIGURE 8. Single-Sided Sample PC Layout for LH0032

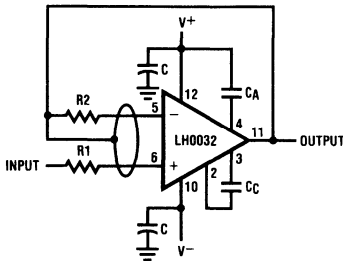
The guard conductor serves to intercept leakage currents from inputs to the surrounding circuit. It is most effective when it is driven to the same potential as the guarded circuit. *Figures 9 and 10* show how the technique is implemented in inverting and non-inverting configurations, respectively.

One other benefit of input guarding is the reduction of input stray capacitance effects. A comprehensive discussion of this technique is described in Application Note AN-63.



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FIGURE 9. Guarding Inverting Figure Amplifier



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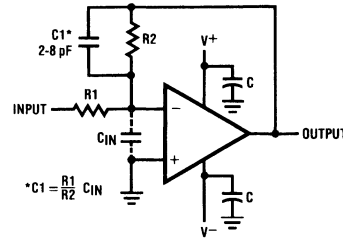
FIGURE 10. Guarding Non-Inverting Unity Gain Amplifier

Input Capacitance Cancellation

The intrinsic input capacitance of the amplifier cannot be totally eliminated by the input guarding technique. This input capacitance introduces a pole in the amplifier response at the frequency given by:

$$f_p = \frac{1}{2\pi R_S C_{IN}} \quad (3)$$

This pole may become extremely important as, for example, a C_{IN} of 5 pF (typical input capacitance of the LH0024 and LH0032) with a 500Ω effective source resistance creates a pole at about 64 MHz—well before the amplifier's natural frequency response rolls off to unity gain at 70 MHz. If closed-loop gain is unity, more than 135° total phase lag is introduced even before the crossover frequency is reached and will destroy phase margin. Oscillation is certain to occur. The solution is to cancel its effect. As shown in *Figure 11*, the lead capacitor C1 across the feedback resistor is used to introduce a zero in the loop response such that it exactly cancels the pole caused by the input RC network.



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FIGURE 11. Compensating Amplifier Input Capacitance

Ideally, the ratio of input capacitance C_{IN} to lead capacitor C_1 should equal the closed-loop gain of the amplifier. Under this condition, exact pole-zero cancellation is realized.

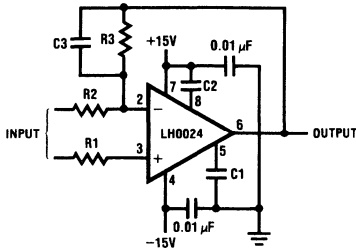
Note that Equation (3) dictates the use of source resistance values less than $1\text{ k}\Omega$ in circuits operating at or near unity gain to keep f_p greater than 70 MHz .

Frequency Compensation

High-performance wideband op amps such as the LH0024 and LH0032 require external frequency compensation, depending on the closed-loop gain. Optimum AC performance will be affected by a given circuit and its layout. Several compensation techniques are recommended and the best should be selected according to the particular application. Each is discussed in the following sections.

Compensating the LH0024

Table II provides a guide to compensate the LH0024 at several values of closed-loop gain. Figure 12 shows the basic scheme.



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FIGURE 12. LH0024 Frequency Compensation Circuit

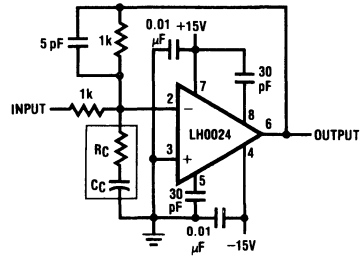
When operating with closed-loop gain of -1 , C_3 is required and may need slight adjustment to completely cancel the input capacitance of the device, typically 5 pF .

TABLE II

Closed-Loop Gain	C1	C2	C3
100	0	0	0
20	0	0	0
10	0	20 pF	1 pF
1	30 pF	30 pF	5 pF

An alternate technique for compensation at a closed-loop gain of 1 is to use an input RC lag compensation network as shown in Figure 13.

With $1\text{ k}\Omega$ resistor values in the circuit, R_C and C_C should be 82Ω and $0.047\text{ }\mu\text{F}$, respectively. The difficulty in using this compensation is its involved calculation and experimenting required in order to find the optimum R_C and C_C values if resistors other than $1\text{ k}\Omega$ are used when the above R_C and C_C values are no longer valid and must be redetermined. For this reason, optimum compensation is almost always determined empirically, as were the values given.



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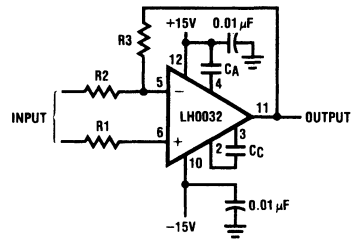
FIGURE 13. Input RC Lag Compensation Circuit

Compensating the LH0032

With the LH0032, two compensation schemes may be used, depending on the designer's specific needs.

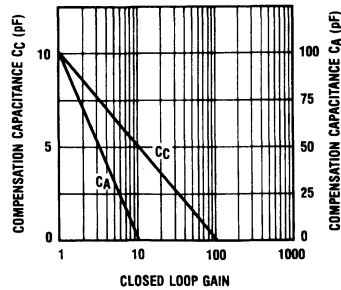
The first technique is shown in Figure 14. It offers the best 0.1% settling time for a $\pm 10\text{V}$ square wave input. The compensation capacitors C_C and C_A should be selected from Figure 15 for various closed-loop gains. Figure 16 shows how the LH0032 frequency response is modified for different value compensation capacitors.

Although this approach offers the shortest settling time, the falling edge exhibits overshoot up to 30% lasting 200 to 300 ns. Figure 17 shows the typical pulse response.



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FIGURE 14. LH0032 Frequency Compensation Circuit



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FIGURE 15. Recommended Value of Compensation Capacitor vs. Closed-Loop Gain for Optimum Settling Time

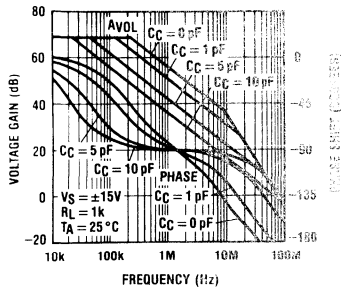


FIGURE 16. The Effect of Various Compensation Capacitors on LH0032 Open Loop Frequency Response

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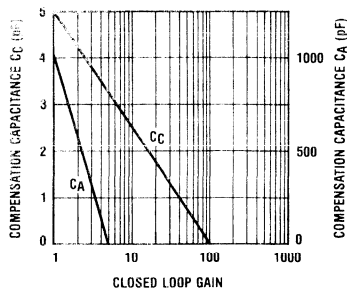


FIGURE 18. Recommended Value of Compensation Capacitor vs. Closed-Loop Gain for Optimum Slew Rate

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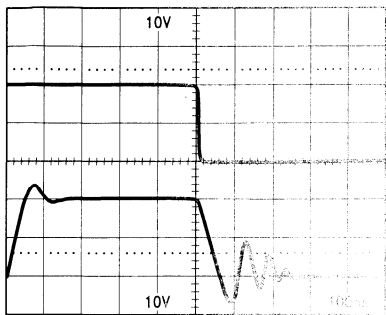


FIGURE 17. LH0032 Unity Gain Non-Inverting Large Signal Pulse Response: TA = 25°C, Cc = 10 pF, CA = 100 pF

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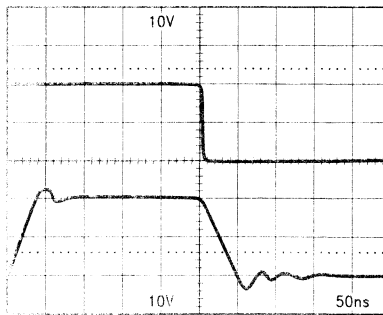


FIGURE 19. LH0032 Unity Gain Non-Inverting Large Signal Pulse Response: Cc = 5 pF, CA = 1000 pF

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If obtaining minimum ringing at the falling edge is the primary objective, a slight modification to the circuit is recommended. It is based on the same circuit as that of Figure 14. The values of the unity gain compensation capacitor C_C and C_A should be modified to 5 pF and 1000 pF, respectively. Figure 18 shows the suitable capacitance to use for various closed-loop gains. The resulting unity gain output response waveform is shown in Figure 19. The settling time to 1% final value is actually superior to the first method of compensation. However, the LH0032 suffers slow settling thereafter to 0.1% accuracy at the falling edge, and nearly four times as much at the rising edge, compared to the previous scheme. Note, however, that the falling edge settling is considerably reduced. Furthermore, the slew rate is consistently superior using this compensation because of the smaller value of Miller capacitance C_C required. Typical improvement is as much as 50%. A more detailed discussion of this effect is provided in the Slew Response section of this Application Note.

The second compensation scheme works well with both inverting or non-inverting modes. Figure 20 shows the circuit

schematic, in which a 270Ω resistor and a 0.01 μF capacitor are connected across the inputs of the device. This lag compensation introduces a zero in the loop modifying the response such that adequate phase margin is preserved at unity gain crossover frequency. Note that the circuit requires no additional compensation.

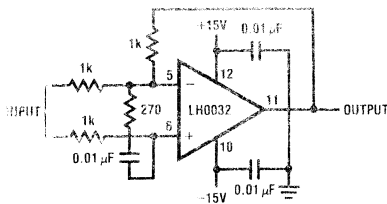


FIGURE 20. LH0032 Non-Compensated Unity Gain Compensation

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Output Drive Capability

The LH0024 and LH0032 op amps are designed to deliver, but not to exceed, ± 100 mA peak output current for durations under $1 \mu\text{s}$ at duty cycles under 1%.

The output drive capability of these op amps is limited primarily by device power dissipation. Figure 21 shows the maximum drive capabilities under various conditions. These limits should be observed. Furthermore, the open loop gain decreases slightly as a result of increased output loading. For this reason, continuous output current should be kept under 50 mA.

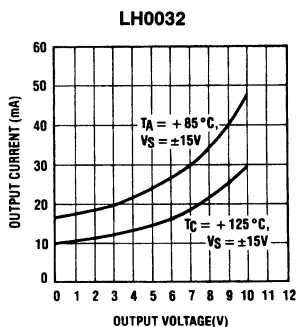
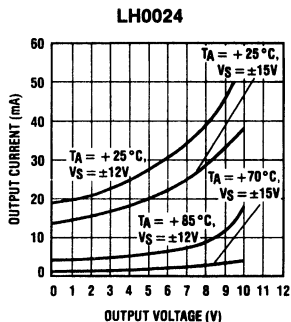


FIGURE 21. Continuous Output Drive Capability

Capacitive Load Compensation

Capacitive loads cause increased phase shifts in such a way that phase margin decreases toward an unstable state and oscillating may result. The cure is to overcompensate the op amp and to isolate the load with a series resistor (100 to 200 Ω) as shown in Figure 22. For example, an unterminated coaxial cable presents a capacitive load. Slight overcompensation may be required to maintain stability.

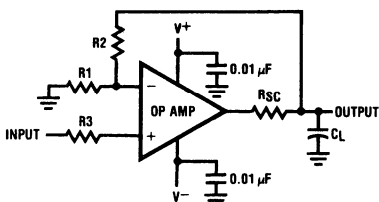


FIGURE 22. Output Protection when Driving Capacitive Load

Power Dissipation

A simple design rule that is often bent, if not broken, is that relating to power dissipation. The limits for the LH0024 and LH0032 are shown in Figure 23. Under no circumstances should these guidelines be exceeded within the temperature range specified. The total power dissipation can be easily calculated from the following equation:

$$P_{\text{Total}} = P_Q + P_{\text{Out}} \quad (4)$$

Where: P_Q = the quiescent power at a given supply voltage and current as specified by the data sheet, and,

P_{Out} = the drive power dissipated in the device output stage, computed as the net rms collector-emitter voltage of the output transistor times the load current.

Determining power dissipation when driving a capacitive load is more involved. The peak power required to charge or discharge the load capacitor is:

$$P_{\text{Peak}} = \frac{C_L (\Delta V)^2}{t} \quad (5)$$

Where: ΔV = the change in voltage across C_L .

t = I_{Peak} charging time into C_L .

Over a full charge and discharge cycle, the power is directly proportional to the frequency of the input pulse waveform. As the pulse repetition frequency increases, so does power dissipation.

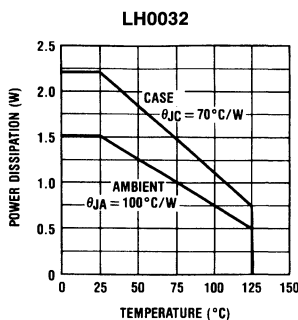
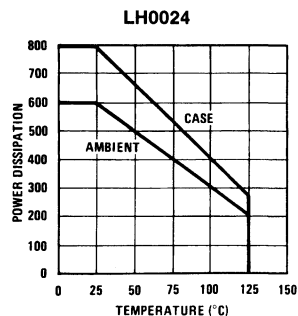


FIGURE 23. Maximum Power Dissipation

Short Circuit Protection

Since the LH0024 and LH0032 have no internal short circuit protection, their relatively high drive capability can sustain current levels sufficient to destroy the devices if high frequency oscillation is induced. This can occur with a large capacitance load. To design in protection, a current limiting resistor R_{sc} should be inserted at the output of the amplifier inside the feedback loop as shown in *Figure 22*. The value of R_{sc} can be determined from the following equation:

$$R_{sc} = \frac{V^+}{I_{sc}} \quad (6)$$

Where: V^+ is the power supply voltage.

Heat Sinking Considerations

Under severe environmental and electrical operating conditions, a low thermal resistance heat sink should be used to assure safe operation. The following is a list of heat sinks from various sources recommended for the TO-8 case style:

Thermalloy 2240A, 33°C/W

Wakefield 215CB, 30°C/W

IERC, UP-TO 8-48CB, 15°C/W

Heat sinks for the TO-5 case style are readily available from many manufacturers. A reasonably priced clip-on unit from Thermalloy, Model 2228B, offers modest thermal resistance of 35°C/W.

Case Grounding

Grounding the case of the device offers improved immunity from circuit cross-talk, but it compromises additional stray capacitance to every device pin (usually 1–2 pF). In the rare situation where case grounding is required, slight recompensation may be necessary. However, most applications are not demanding enough to warrant its use.

There are several ways to strap, or ground the case. For the LH0032, the best approach is to solder a small metal washer or a small piece of wire between the base of the device metal can and the base of an unassigned lead post. Dedicating pin 7 of the LH0032 for this purpose is recommended, although any other "no connection" pin is acceptable. High temperature solder should be used to avoid solder reflow during normal assembly operations.

The LH0024 has no unused pins available, and thus is not readily adaptable to case strapping. An alternative approach is to use an electrically conductive heatsink with a PC board-mountable option, such as Thermalloy type 2230C-5.

In all uses of case grounding, be on the lookout for ground-induced noise into the signal path. In short, be sure the ground is a *quiet* ground.

Power Supply Bypass

Power supply pins must be bypassed in all cases to prevent oscillation. A 0.01 μ F to 0.1 μ F disc or monolithic ceramic capacitor at each supply pin to ground is adequate. The capacitors should be placed no more than $\frac{1}{2}$ inch from the device pins.

Adjustment of Offset Voltages

When required, the offset voltage of the operational amplifiers may be nulled using a balance potentiometer as shown in *Figure 24*. The 100 Ω series resistors prevent any adverse oscillation or malfunction when the pot is shorted to either end of the adjustment range.

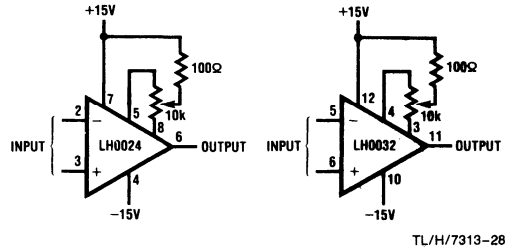


FIGURE 24. Offset Voltage Adjustment

Slew Response Improvement

Slew rate is the internally limited maximum rate of rise, or fall, at maximum amplifier output swing when driven by a large signal step input. It is primarily limited by the operating current of the input stage. When overdriven by a step function, the input stage operating current charges or discharges the effective circuit capacitance of the second stage. The rate of charge is:

$$\frac{dV}{dt} = \frac{I_{\text{Input Stage}}}{C_{\text{Node}}} \quad (7)$$

In the case of the LH0032, where Miller Compensation is used, the external capacitance adds to the internal circuit capacitance, resulting in reduced slew rate. *Figure 25* illustrates this effect as a function of the capacitance value.

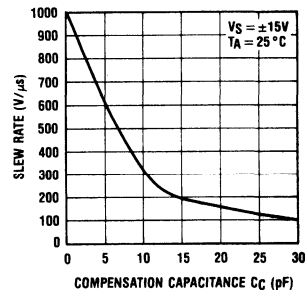
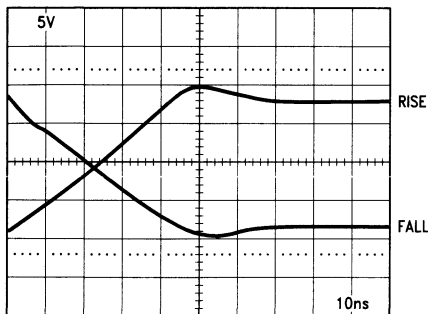


FIGURE 25. LH0032 Slew Rate vs. Frequency Compensation Capacitance

Figures 26, 27, and 28 demonstrate the rising and falling slew capabilities of the LH0024 and LH0032. Notice the improved slew rate performance of the LH0032 using the alternative compensation technique in Figure 28 compared to Figure 27. The difference is due to the smaller Miller capacitance used in the former.

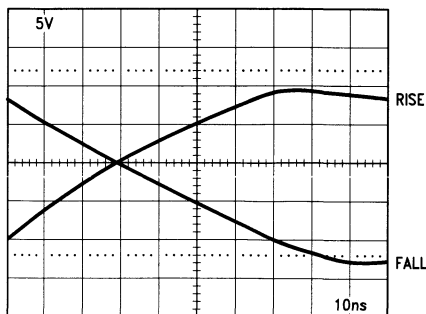
The LH0024 does not use Miller Compensation, so slew rate is not compromised. Consequently, large signal frequency response is significantly higher than that of the LH0032.

Finally, power supply voltage affects slew rate. As the voltage decreases, input stage operating current decreases accordingly. The net effect is a reduction in the slew rate as the available charging current drops off. Figure 29 shows the typical slew response of each op amp as a function of supply voltage.



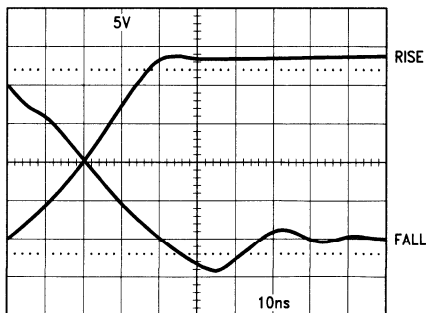
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FIGURE 26. LH0024 Slew Response, Unity Gain Inverting Mode



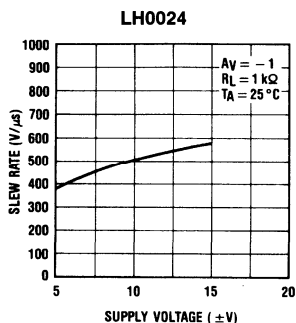
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FIGURE 27. LH0032 Slew Response, Unity Gain Inverting Mode, Standard Compensation ($C_C = 10 \text{ pF}$, $C_A = 100 \text{ pF}$)

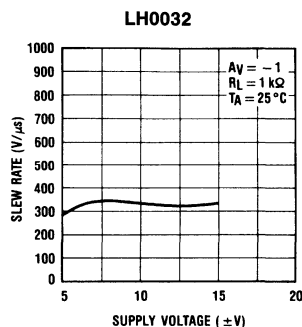


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FIGURE 28. LH0032 Slew Response, Unity Gain Inverting Mode, Improved Compensation ($C_C = 5 \text{ pF}$, $C_A = 1000 \text{ pF}$)



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TL/H/7313-34

FIGURE 29. Slew Rate Response as a Function of Supply Voltages

Settling Time

Settling time is the time between the start of a step input to the time it takes the output to settle to within a specified error band of the final voltage. This parameter is heavily influenced by the frequency compensation of the amplifier (degree of damping). Undercompensation results in excessive phase shift, overshoot and ringing, and therefore, a long settling time. Equally poor performance results from overcompensation, which yields an overdamped system, slow decay and, again, a long settling time.

Expectedly, settling time is affected by the loop gain of the amplifier. *Figure 30* illustrates this effect for these two devices.

One of the most demanding applications is driving a capacitive load in a circuit such as a high speed sample-and-hold, where accuracy and fast settling time are both important. Because of the additional phase shift introduced by driving the sampling capacitor, the LH0032 must be recomensated. *Figure 31* presents the optimum compensation to obtain fastest settling time under these conditions.

CONCLUSION

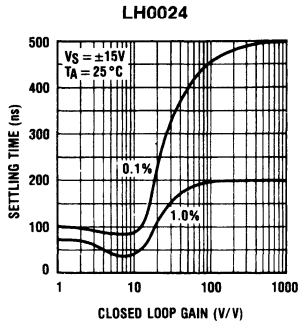
At first glance, the LH0024 and LH0032 seem harmless enough. A more in-depth look reveals the challenges in ap-

plying these high performance op amps. The ultimate capabilities that can be extracted are a direct function of careful engineering. With prudence, these devices are harmless indeed.

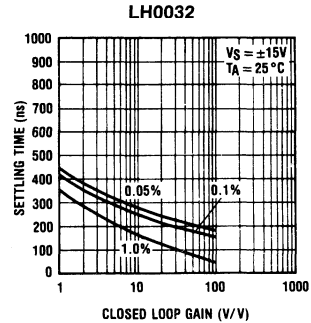
Application of these high performance amplifiers requires an understanding of compensation and layout technique. With the information presented in this note, the designer should be able to enjoy the benefits of their superior capabilities.

REFERENCES

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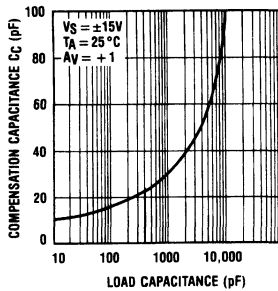


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FIGURE 30. Settling Time vs. Closed-Loop Gain



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FIGURE 31. Frequency Compensation vs. Load Capacitance



1.0 INTRODUCTION

Perhaps one of the more important application areas of digital signal processing (DSP) is the power spectral estimation of periodic and random signals. Speech recognition problems use spectrum analysis as a preliminary measurement to perform speech bandwidth reduction and further acoustic processing. Sonar systems use sophisticated spectrum analysis to locate submarines and surface vessels. Spectral measurements in radar are used to obtain target location and velocity information. The vast variety of measurements spectrum analysis encompasses is perhaps limitless and it will thus be the intent of this article to provide a brief and fundamental introduction to the concepts of power spectral estimation.

Since the estimation of power spectra is statistically based and covers a variety of digital signal processing concepts, this article attempts to provide sufficient background through its contents and appendices to allow the discussion to flow void of discontinuities. For those familiar with the preliminary background and seeking a quick introduction into spectral estimation, skipping to Sections 6.0 through 11.0 should suffice to fill their need. Finally, engineers seeking a more rigorous development and newer techniques of measuring power spectra should consult the excellent references listed in Appendix D and current technical society publications.

As a brief summary and quick lookup, refer to the Table of Contents of this article.

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2.0 WHAT IS A SPECTRUM?

A spectrum is a relationship typically represented by a plot of the magnitude or relative value of some parameter against frequency. Every physical phenomenon, whether it be an electromagnetic, thermal, mechanical, hydraulic or any other system, has a unique spectrum associated with it.

In electronics, the phenomena are dealt with in terms of signals, represented as fixed or varying electrical quantities of voltage, current and power. These quantities are typically described in the time domain and for every function of time, $f(t)$, an equivalent frequency domain function $F(\omega)$ can be found that specifically describes the frequency-component content (frequency spectrum) required to generate $f(t)$. A study of relationships between the time domain and its corresponding frequency domain representation is the subject of Fourier analysis and Fourier transforms.

The *forward Fourier transform*, time to frequency domain, of the function $x(t)$ is defined

$$F[x(t)] = \int_{-\infty}^{\infty} x(t)\epsilon^{-j\omega t} dt = X(\omega) \quad (1)$$

and the *inverse Fourier transform*, frequency to time domain, of $X(\omega)$ is

$$F^{-1}[X(\omega)] = \frac{1}{2\pi} \int_{-\infty}^{\infty} X(\omega)\epsilon^{j\omega t} d\omega = x(t) \quad (2)$$

(For an in-depth study of the Fourier integral see reference 19.) Though these expressions are in themselves self-explanatory, a short illustrative example will be presented to aid in relating the two domains.

If an arbitrary time function representation of a periodic electrical signal, $f(t)$, were plotted versus time as shown in *Figure 1*, its Fourier transform would indicate a spectral content consisting of a DC component, a fundamental frequency component ω_0 , a fifth harmonic component $5\omega_0$ and a ninth harmonic component $9\omega_0$ (see *Figure 2*). It is illustratively seen in *Figure 3* that the superposition of these frequency components, in fact, yields the original time function $f(t)$.

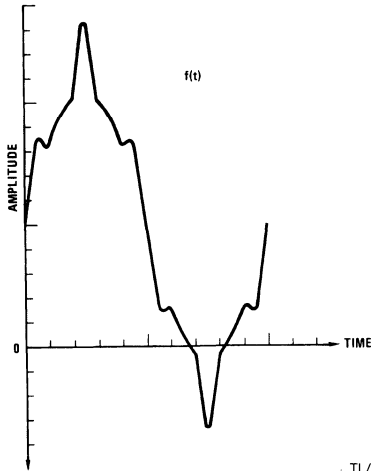


FIGURE 1. An Electrical Signal $f(t)$

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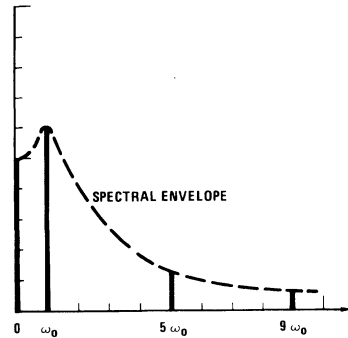


FIGURE 2. Spectral Composition or Spectrum $F(\omega)$ or $f(t)$

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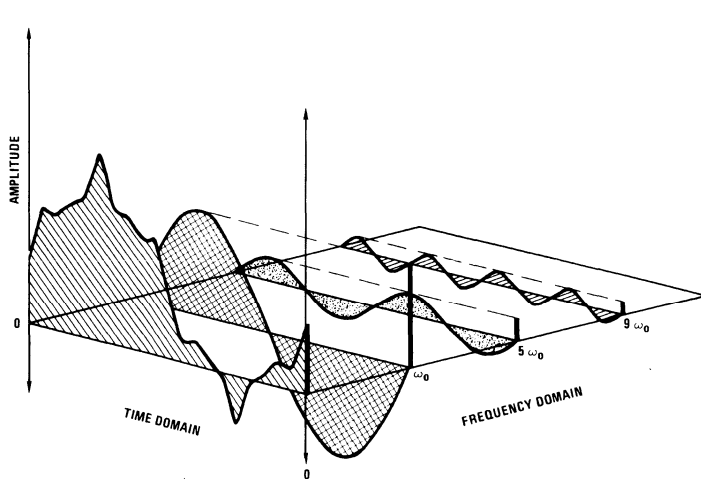


FIGURE 3. Combined Time Domain and Frequency Domain Plots

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3.0 ENERGY AND POWER

In the previous section, time and frequency domain signal functions were related through the use of Fourier transforms. Again, the same relationship will be made in this section but the emphasis will pertain to signal power and energy.

Parseval's theorem relates the representation of energy, $\omega(t)$, in the time domain to the frequency domain by the statement

$$\omega(t) = \int_{-\infty}^{\infty} f_1(t)f_2(t) dt = \int_{-\infty}^{\infty} F_1(f)F_2(f) df \quad (3)$$

where $f(t)$ is an arbitrary signal varying as a function of time and $F(f)$ its equivalent Fourier transform representation in the frequency domain.

The proof of this is simply

$$\int_{-\infty}^{\infty} f_1(t)f_2(t) dt = \int_{-\infty}^{\infty} f_1(t)f_2(t) dt \quad (4a)$$

Letting $F_1(f)$ be the Fourier transform of $f_1(t)$

$$\int_{-\infty}^{\infty} f_1(t)f_2(t) dt = \int_{-\infty}^{\infty} \left[\int_{-\infty}^{\infty} F_1(f)e^{j2\pi ft} df \right] f_2(t) dt \quad (4b)$$

$$= \int_{-\infty}^{\infty} \left[F_1(f) \int_{-\infty}^{\infty} e^{j2\pi ft} dt \right] f_2(t) dt \quad (4c)$$

Rearranging the integrand gives

$$\int_{-\infty}^{\infty} f_1(t)f_2(t) dt = \int_{-\infty}^{\infty} F_1(f) \left[\int_{-\infty}^{\infty} f_2(t)e^{j2\pi ft} dt \right] df \quad (4d)$$

and the factor in the brackets is seen to be $F_2(-f)$ (where $F_2(-f) = F_2^*(f)$ the conjugate of $F_2(f)$) so that

$$\int_{-\infty}^{\infty} f_1(t)f_2(t) dt = \int_{-\infty}^{\infty} F_1(f)F_2(-f) df \quad (4e)$$

A corollary to this theorem is the condition $f_1(t) = f_2(t)$ then $F(-f) = F^*(f)$, the complex conjugate of $F(f)$, and

$$\omega(t) = \int_{-\infty}^{\infty} f^2(t) dt = \int_{-\infty}^{\infty} F(f)F^*(f) df \quad (5a)$$

$$= \int_{-\infty}^{\infty} |F(f)|^2 df \quad (5b)$$

This simply says that the total energy[†] in a signal $f(t)$ is equal to the area under the square of the magnitude of its Fourier transform. $|F(f)|^2$ is typically called the *energy density*, *spectral density*, or *power spectral density* function and $|F(f)|^2 df$ describes the density of signal energy contained in the differential frequency band from f to $f + df$.

In many electrical engineering applications, the instantaneous signal power is desired and is generally assumed to be equal to the square of the signal amplitudes i.e., $f^2(t)$.

[†]Recall the energy storage elements

$$\text{Inductor} \quad v = L \frac{di}{dt}$$

$$\omega(t) = \int_0^T v i dt = \int_0^T L \frac{di}{dt} i dt = \int_0^I L i di = \frac{1}{2} L I^2$$

$$\text{Capacitor} \quad i = C \frac{dv}{dt}$$

$$\omega(t) = \int_0^T v i dt = \int_0^T v C \frac{dv}{dt} dt = \int_0^V C v dv = \frac{1}{2} C V^2$$

This is only true, however, assuming that the signal in the system is impressed across a 1Ω resistor. It is realized, for example, that if $f(t)$ is a voltage (current) signal applied across a system resistance R , its true instantaneous power would be expressed as $[f(t)]^2/R$ (or for current $[f(t)]^2R$) thus, $[f(t)]^2$ is the true power only if $R = 1\Omega$.

So for the general case, power is always proportional to the square of the signal amplitude varied by a proportionality constant R , the impedance level in a circuit. In practice, however, it is undesirable to carry extra constants in the computation and customarily for signal analysis, one assumes signal measurement across a 1Ω resistor. This allows units of power to be expressed as the square of the signal amplitudes and the units of energy measured as volts²-second (amperes²-second).

For periodic signals, equation (5) can be used to define the average power, P_{avg} , over a time interval t_2 to t_1 by integrating $[f(t)]^2$ from t_1 to t_2 and then obtaining the average after dividing the result by $t_2 - t_1$ or

$$P_{avg} = \frac{1}{t_2 - t_1} \int_{t_1}^{t_2} f^2(t) dt \quad (6a)$$

$$= \frac{1}{T} \int_0^T f^2(t) dt \quad (6b)$$

where T is the period of the signal.

Having established the definitions of this section, energy can now be expressed in terms of power, $P(t)$,

$$\omega(t) = \int_{-\infty}^{\infty} [f(t)]^2 dt \quad (7a)$$

$$= \int_{-\infty}^{\infty} P(t) dt \quad (7b)$$

with power being the time rate of change of energy

$$P(t) = \frac{d\omega(t)}{dt} \quad (8)$$

As a final clarifying note, again, $|F(f)|^2$ and $P(t)$, as used in equations (7b) and (8), are commonly called throughout the technical literature, *energy density*, *spectral density*, or *power spectral density* functions, PSD. Further, PSD may be interpreted as the average power associated with a bandwidth of one hertz centered at f hertz.

4.0 RANDOM SIGNALS

It was made apparent in previous sections that the use of Fourier transforms for analysis of linear systems is widespread and frequently leads to a saving in labor.

In view of using frequency domain methods for system analysis, it is natural to ask if the same methods are still applicable when considering a random signal system input. As will be seen shortly, with some modification, they *will* still be useful and the modified methods offer essentially the same advantages in dealing with random signals as with nonrandom signals.

It is appropriate to ask if the Fourier transform may be used for the analysis of any random sample function. Without proof, two reasons can be discussed which make the transform equations (1) and (2) invalid.

Firstly, $X(\omega)$ is a random variable since, for any fixed ω , each sample would be represented by a different value of the ensemble of possible sample functions. Hence, it is not a frequency representation of the process but only of one member of the process. It might still be possible, however, to use this function by finding its mean or expected value over the ensemble except that the second reason negates this approach. The second reason for not using the $X(\omega)$ of equations (1) and (2) is that, for stationary processes, it almost never exists. As a matter of fact, one of the conditions for a time function to be Fourier transformable is that it be integrable so that,

$$\int_{-\infty}^{\infty} |x(t)| dt < \infty \quad (9)$$

A sample from a stationary random process can never satisfy this condition (with the exception of generalized functions inclusive of impulses and so forth) by the argument that if a signal has nonzero power, then it has infinite energy and if it has finite energy then it has zero power (average power). Shortly, it will be seen that the class of functions having no Fourier integral, due to equation (9), but whose average power is finite can be described by statistical means.

Assuming $x(t)$ to be a sample function from a stochastic process, a truncated version of the function $x_T(t)$ is defined as

$$x_T(t) = \begin{cases} x(t) & |t| \leq T \\ 0 & |t| > T \end{cases} \quad (10)$$

and

$$x(t) = \lim_{T \rightarrow \infty} x_T(t) \quad (11)$$

This truncated function is defined so that the Fourier transform of $x_T(t)$ can be taken. If $x(t)$ is a power signal, then recall that the transform of such a signal is not defined

$$\int_{-\infty}^{\infty} |x(t)| dt \text{ not less than } \infty \quad (12)$$

but that

$$\int_{-\infty}^{\infty} |x_T(t)| dt < \infty \quad (13)$$

The Fourier transform pair of the truncated function $x_T(t)$ can thus be taken using equations (1) and (2). Since $x(t)$ is a power signal, there must be a power spectral density function associated with it and the total area under this density must be the average power despite the fact that $x(t)$ is non-Fourier transformable.

Restating equation (5) using the truncated function $x_T(t)$

$$\int_{-\infty}^{\infty} x_T^2(t) dt = \int_{-\infty}^{\infty} |X_T(f)|^2 df \quad (14)$$

and dividing both sides by $2T$

$$\frac{1}{2T} \int_{-\infty}^{\infty} x_T^2(t) dt = \frac{1}{2T} \int_{-\infty}^{\infty} |X_T(f)|^2 df \quad (15)$$

gives the left side of equation (15) the physical significance of being proportional to the average power of the sample function in the time interval $-T$ to T . This assumes $x_T(t)$ is a voltage (current) associated with a resistance. More precisely, it is the square of the *effective value* of $x_T(t)$

and for an ergodic process approaches the *mean-square* value of the process as T approaches infinity.

At this particular point, however, the limit as T approaches infinity cannot be taken since $X_T(f)$ is non-existent in the limit. Recall, though, that $X_T(f)$ is a random variable with respect to the ensemble of sample functions from which $x(t)$ was taken. The limit of the *expected value* of

$$\frac{1}{2T} |X_T(f)|^2$$

can be reasonably assumed to exist since its integral, equation (15), is always positive and certainly does exist. If the expectations $E\{ \}$, of both sides of equation (15) are taken

$$E \left\{ \frac{1}{2T} \int_{-\infty}^{\infty} x_T^2(t) dt \right\} = E \left\{ \frac{1}{2T} \int_{-\infty}^{\infty} |X_T(f)|^2 df \right\} \quad (16)$$

then interchanging the integration and expectation and at the same time taking the limit as $T \rightarrow \infty$

$$\lim_{T \rightarrow \infty} \frac{1}{2T} \int_{-\infty}^{\infty} \overline{x^2(t)} dt = \lim_{T \rightarrow \infty} \frac{1}{2T} \int_{-\infty}^{\infty} E\{|X_T(f)|^2\} df \quad (17)$$

results in

$$\overline{\langle x^2(t) \rangle} = \int_{-\infty}^{\infty} \lim_{T \rightarrow \infty} \frac{E\{|X_T(f)|^2\}}{2T} df \quad (18)$$

where $\overline{x^2(t)}$ is defined as the mean-square value ($\overline{\quad}$ denotes ensemble averaging and $\langle \quad \rangle$ denotes time averaging).

For stationary processes, the time average of the mean-square value is equal to the mean-square value so that equation (18) can be restated as

$$\overline{x^2(t)} = \int_{-\infty}^{\infty} \lim_{T \rightarrow \infty} \frac{E\{|X_T(f)|^2\}}{2T} df \quad (19)$$

The integrand of the right side of equation (19), similar to equation (5b), is called the *energy density spectrum* or *power spectral density* function of a random process and will be designated by $S(f)$ where

$$S(f) = \lim_{T \rightarrow \infty} \frac{E\{|X_T(f)|^2\}}{2T} \quad (20)$$

Recall that letting $T \rightarrow \infty$ is not possible before taking the expectation.

Similar to the argument in Section III, the physical interpretation of power spectral density can be thought of in terms of average power. If $x(t)$ is a voltage (current) associated with a 1Ω resistance, $x^2(t)$ is just the average power dissipated in that resistor and $S(f)$ can be interpreted as the average power associated with a bandwidth of one hertz centered at f hertz.

$S(f)$ has the units volts²-second and its integral, equation (19), leads to the mean square value hence,

$$\overline{x^2(t)} = \int_{-\infty}^{\infty} S(f) df \quad (21)$$

Having made the tie between the power spectral density function $S(f)$ and statistics, an important theorem in power spectral estimation can now be developed.

Using equation (20) and recalling that $X_T(f)$ is the Fourier transform of $x_T(t)$, assuming a nonstationary process,

$$S(f) = \lim_{T \rightarrow \infty} \frac{E\{|X_T(f)|^2\}}{2T} \quad (22)$$

$$S(f) = \lim_{T \rightarrow \infty} \frac{1}{2T} E \left\{ \int_{-\infty}^{\infty} x_T(t_1) e^{j\omega t_1} dt_1 \int_{-\infty}^{\infty} x_T(t_2) e^{j\omega t_2} dt_2 \right\} \quad (23)$$

Note that $|X_T(f)|^2 = X_T(f)X_T^*(-f)$ and that in order to distinguish the variables of integration when equation (23) is re-manipulated the subscripts of t_1 and t_2 have been introduced. So, (see Appendix B)

$$S(f) = \lim_{T \rightarrow \infty} \left\{ \frac{1}{2T} E \left[\int_{-\infty}^{\infty} dt_2 \int_{-\infty}^{\infty} \epsilon^{-j\omega(t_2-t_1)} x_T(t_1)x_T(t_2) dt_1 \right] \right\} \\ = \lim_{T \rightarrow \infty} \left\{ \frac{1}{2T} \int_{-\infty}^{\infty} dt_2 \int_{-\infty}^{\infty} E[x_T(t_1)x_T(t_2)] \epsilon^{-j\omega(t_2-t_1)} dt_1 \right\} \quad (24)$$

Finally, the expectation $E[x_T(t_1)x_T(t_2)]$ is recognized as the autocorrelation, $R_{xx}(t_1, t_2)$ (Appendix A.14) function of the truncated process where

$$E[x_T(t_1)x_T(t_2)] = R_{xx}(t_1, t_2) \quad |t_1|, |t_2| \leq T \\ = 0 \quad \text{everywhere else.}$$

Substituting

$$t_2 - t_1 = \tau \quad (26)$$

$$dt_2 = d\tau \quad (27)$$

equation (25) next becomes

$$S(f) = \lim_{T \rightarrow \infty} \frac{1}{2T} \int_{-\infty}^{\infty} d\tau \int_{-T}^T R_{xx}(t_1, t_1 + \tau) \epsilon^{-j\omega\tau} dt \quad (28)$$

or

$$S(f) = \left\{ \left[\int_{-\infty}^{\infty} \lim_{T \rightarrow \infty} \frac{1}{2T} \int_{-T}^T R_{xx}(t_1, t_1 + \tau) dt_1 \right] \epsilon^{-j\omega\tau} d\tau \right\} \quad (29)$$

We see then that the special density is the Fourier transform of the time average of the autocorrelation function. The relationship of equation (29) is valid for a nonstationary process.

For the stationary process, the autocorrelation function is independent of time and therefore

$$\langle R_{xx}(t_1, t_1 + \tau) \rangle = R_{xx}(\tau) \quad (30)$$

From this it follows that the spectral density of a stationary random process is just the Fourier transform of the autocorrelation function where

$$S(f) = \int_{-\infty}^{\infty} R_{xx}(\tau) \epsilon^{-j\omega\tau} d\tau \quad (31)$$

and

$$R_{xx}(\tau) = \int_{-\infty}^{\infty} S(f) \epsilon^{j\omega\tau} df \quad (32)$$

are described as the Wiener-Khinchine theorem.

The Wiener-Khinchine relation is of fundamental importance in analyzing random signals since it provides a link between the time domain [correlation function, $R_{xx}(\tau)$] and the frequency domain [spectral density, $S(f)$]. Note that the uniqueness is in fact the Fourier transformability. It follows, then, for a stationary random process that the autocorrelation function is the inverse transform of the spectral density function. For the nonstationary process, however, the autocorrelation function cannot be recovered from the spectral density. Only the time average of the correlation is recoverable, equation (29).

Having completed this section, the path has now been paved for a discussion on the techniques used in power spectral estimation.

5.0 FUNDAMENTAL PRINCIPLES OF ESTIMATION THEORY

When characterizing or modeling a random variable, estimates of its statistical parameters must be made since the data taken is a finite sample sequence of the random process.

Assume a random sequence $x(n)$ from the set of random variables $\{x_n\}$ to be a realization of an ergodic random process (random for which ensemble or probability averages, $E[\]$, are equivalent to time averages, $\langle \ \rangle$) where for all n ,

$$m = E[x_n] = \int_{-\infty}^{\infty} x f_x(x) dx \quad (33)$$

Assuming further that the estimate of the desired averages of the random variables $\{x_n\}$ from a finite segment of the sequence, $x(n)$ for $0 \leq n \leq N-1$, to be

$$m = \langle x_n \rangle = \lim_{N \rightarrow \infty} \frac{1}{2N+1} \sum_{n=-N}^N x_n \quad (34)$$

then for each sample sequence

$$m = \langle x(n) \rangle = \lim_{N \rightarrow \infty} \frac{1}{2N+1} \sum_{n=-N}^N x(n) \quad (35)$$

Since equation (35) is a precise representation of the mean value in the limit as N approaches infinity then

$$\hat{m} = \frac{1}{N} \sum_{n=0}^{N-1} x(n) \quad (36)$$

may be regarded as a fairly accurate estimate of m for sufficiently large N . The caret (\wedge) placed above a parameter is representative of an estimate. The area of statistics that pertains to the above situations is called *estimation theory*. Having discussed an elementary statistical estimate, a few common properties used to characterize the estimator will next be defined. These properties are *bias*, *variance* and *consistency*.

Bias

The difference between the mean or expected value $E[\hat{\eta}]$ of an estimate $\hat{\eta}$ and its true value η is called the *bias*.

$$\text{bias} = B_{\hat{\eta}} = \eta - E[\hat{\eta}] \tag{37}$$

Thus, if the mean of an estimate is equal to the true value, it is considered to be *unbiased* and having a *bias* value equal to zero.

Variance

The variance of an estimator effectively measures the width of the probability density (Appendix A.4) and is defined as

$$\sigma_{\hat{\eta}}^2 = E\left[\left(\hat{\eta} - E[\hat{\eta}]\right)^2\right] \tag{38}$$

A good estimator should have a small variance in addition to having a small bias suggesting that the probability density function is concentrated about its mean value. The mean square error associated with this estimator is defined as

$$\text{mean square error} = E\left[\left(\hat{\eta} - \eta\right)^2\right] = \sigma_{\hat{\eta}}^2 + B_{\hat{\eta}}^2 \tag{39}$$

Consistency

If the bias and variance both tend to zero as the limit tends to infinity or the number of observations become large, the estimator is said to be consistent. Thus,

$$\lim_{N \rightarrow \infty} \sigma_{\hat{\eta}}^2 = 0 \tag{40}$$

and

$$\lim_{N \rightarrow \infty} B_{\hat{\eta}} = 0 \tag{41}$$

This implies that the estimator converges in probability to the true value of the quantity being estimated as N becomes infinite.

In using estimates the mean value estimate of m_x , for a Gaussian random process is the *sample mean* defined as

$$\hat{m}_x = \frac{1}{N} \sum_{i=0}^{N-1} x_i \tag{42}$$

the mean square value is computed as

$$E[\hat{m}_x^2] = \frac{1}{N^2} \sum_{i=0}^{N-1} \sum_{j=0}^{N-1} E[x_i x_j] \tag{43}$$

$$= \frac{1}{N^2} \left[\sum_{i=0}^{N-1} E[x_i^2] + \sum_{i=0}^{N-1} \sum_{\substack{j=0 \\ j \neq i}}^{N-1} E[x_i] \cdot E[x_j] \right] \tag{44}$$

$$= \frac{1}{N^2} \left[N(E[x_n^2]) + \left(\sum_{i=0}^{N-1} E[x_i] \right) \left(\sum_{\substack{j=0 \\ j \neq i}}^{N-1} E[x_j] \right) \right] \tag{45}$$

$$= \frac{1}{N} E[x_n^2] + (m_x)^2 \frac{N-1}{N} \tag{46}$$

thus allowing the variance to be stated as

$$\sigma_{\hat{m}_x}^2 = E[(\hat{m}_x)^2] - \{E[\hat{m}_x]\}^2 \tag{47}$$

$$= \frac{1}{N} E[x_n^2] + (m_x)^2 \frac{N-1}{N} - \{E[\hat{m}_x]\}^2 \tag{48}$$

$$= \frac{1}{N} E[x_n^2] + (m_x)^2 \frac{N-1}{N} - m_x^2 \tag{49}$$

$$= \frac{1}{N} (E[x_n^2] - m_x^2) \tag{50}$$

$$= \frac{\sigma_x^2}{N} \tag{51}$$

This says that as the number of observations N increase, the variance of the sample mean decreases, and since the bias is zero, the sample mean is a consistent estimator.

If the variance is to be estimated and the mean value is a known then

$$\hat{\sigma}_x^2 = \frac{1}{N} \sum_{i=0}^{N-1} (x_i - m_x)^2 \tag{52}$$

this estimator is consistent.

If, further, the mean and the variance are to be estimated then the sample variance is defined as

$$\hat{\sigma}_x^2 = \frac{1}{N} \sum_{i=0}^{N-1} (x_i - \hat{m}_x)^2 \tag{53}$$

again \hat{m}_x is the sample mean.

The only difference between the two cases is that equation (52) uses the true value of the mean, whereas equation (53) uses the estimate of the mean. Since equation (53) uses an estimator the bias can be examined by computing the expected value of $\hat{\sigma}_x^2$ therefore,

$$E[\hat{\sigma}_x^2] = \frac{1}{N} \sum_{i=0}^{N-1} (E[x_i] - E[\hat{m}_x])^2 \tag{54}$$

$$= \frac{1}{N} \sum_{i=0}^{N-1} \left\{ E[x_i^2] - 2E[x_i \hat{m}_x] + E[\hat{m}_x^2] \right\} \tag{55}$$

$$= \frac{1}{N} \sum_{i=0}^{N-1} E[x_i^2] - \frac{2}{N^2} \sum_{i=0}^{N-1} \left(\sum_{j=0}^{N-1} \right) \tag{56}$$

$$E[x_i x_j] \Big) + \frac{1}{N^2} \sum_{i=0}^{N-1} \sum_{j=0}^{N-1} E[x_i x_j]$$

$$= \frac{1}{N} \sum_{i=0}^{N-1} E[x_i^2] - \frac{2}{N^2} \left(\sum_{i=0}^{N-1} E[x_i^2] + \sum_{\substack{i=0 \\ i \neq j}}^{N-1} \sum_{j=0}^{N-1} E[x_i] \cdot E[x_j] \right) + \frac{1}{N^2} \left(\sum_{i=0}^{N-1} E[x_i^2] + \sum_{i=0}^{N-1} \sum_{j=0}^{N-1} E[x_i] \cdot E[x_j] \right) \quad (57)$$

$$= \frac{1}{N} \left(N \cdot E[x_i^2] \right) - \frac{2}{N^2} \left[N \cdot E[x_i^2] + N(N-1)m_x^2 \right] + \frac{1}{N^2} \left[N \cdot E[x_i^2] + N(N-1)m_x^2 \right] \quad (58)$$

$$= \frac{1}{N} \left(N \cdot E[x_i^2] \right) - \frac{2N}{N^2} \left(E[x_i^2] \right) - \frac{2N(N-1)}{N^2} m_x^2 + \frac{N}{N^2} E[x_i^2] + \frac{N(N-1)}{N^2} m_x^2 \quad (59)$$

$$= \frac{1}{N} \left(N \cdot E[x_i^2] \right) - \frac{2}{N} \left(E[x_i^2] \right) - \frac{2(N-1)}{N} m_x^2 + \frac{1}{N} E[x_i^2] + \frac{(N-1)}{N} m_x^2 \quad (60)$$

$$= \frac{1}{N} (N - E[x_i^2]) - \frac{1}{N} (E[x_i^2]) - \frac{(N-1)}{N} m_x^2 \quad (61)$$

$$= \frac{(N-1)}{N} (E[x_i^2]) - \frac{(N-1)}{N} m_x^2 \quad (62)$$

$$= \frac{(N-1)}{N} \sigma_x^2 \quad (63)$$

It is apparent from equation (63) that the mean value of the sample variance does not equal the variance and is thus biased. Note, however, for large N the mean of the sample variance asymptotically approaches the variance and the estimate virtually becomes unbiased. Next, to check for consistency, we will proceed to determine the variance of the estimate sample variance. For ease of understanding, assume that the process is zero mean, then letting

$$\psi = \hat{\sigma}_x^2 = \frac{1}{N} \sum_{i=0}^{N-1} x_i^2 \quad (64)$$

so that,

$$E[\psi^2] = \frac{1}{N^2} \sum_{i=1}^N \sum_{k=1}^N E[x_i^2 x_k^2] \quad (65)$$

$$= \frac{1}{N^2} \left[N E[x_n^4] + N(N-1) (E[x_n^2])^2 \right] \quad (66)$$

$$= \frac{1}{N} \left[E[x_n^4] + (N-1)(E[x_n^2])^2 \right] \quad (67)$$

the expected value

$$E[\psi] = E[x_n^2] \quad (68)$$

so finally

$$\text{var}[\hat{\sigma}_x^2] = E[\psi^2] - (E[\psi])^2 \quad (69)$$

$$= \frac{1}{N} \left[E[x_n^4] - (E[x_n^2])^2 \right] \quad (70)$$

Re-examining equations (63) and (70) as N becomes large clearly indicates that the sample variance is a consistent estimate. Qualitatively speaking, the accuracy of this estimate depends upon the number of samples considered in the estimate. Note also that the procedures employed above typify the style of analysis used to characterize estimators.

6.0 THE PERIODOGRAM

The first method defines the sampled version of the Wiener-Khinchine relation, equations (31) and (32), where the power spectral density estimate $S_{N_{xx}}(f)$ is the discrete Fourier transform of the autocorrelation estimate $R_{N_{xx}}(k)$ or

$$S_{N_{xx}}(f) = \sum_{k=-\infty}^{\infty} R_{N_{xx}}(k) \epsilon^{-j\omega k T} \quad (71)$$

This assumes that $x(n)$ is a discrete time random process with an autocorrelation function $R_{N_{xx}}(k)$.

For a finite sequence of data

$$x(n) = \begin{cases} x_n & \text{for } n = 0, 1, \dots, N-1 \\ 0 & \text{elsewhere} \end{cases} \quad (72)$$

called a rectangular data window, the sample autocorrelation function (sampled form of equation A.14-9)

$$R_{N_{xx}}(k) = \frac{1}{N} \sum_{n=-\infty}^{\infty} x(n)x(n+k) \quad (73)$$

can be substituted into equation (71) to give the spectral density estimate

$$S_{N_{xx}}(f) = \frac{1}{N} |X_N(f)|^2 \quad (74)$$

called the periodogram.

$$\left(\text{Note: } \frac{|X_N(f)|^2}{N} = \frac{X_N(f)X_N^*(f)}{N} = \frac{X_N^2(f)_{\text{real}} + X_N^2(f)_{\text{imag}}}{N} = F \left[R_{N_{xx}}(k) \right] = F \left[E[x(n)x(n+k)] \right] \right).$$

Hence,

$$S_{N_{xx}}(f) = \sum_{k=-\infty}^{\infty} R_{N_{xx}}(k) \epsilon^{-j\omega k T} \quad (75)$$

$$= \sum_{k=-\infty}^{\infty} \left[\frac{1}{N} \sum_{n=-\infty}^{\infty} x(n)x(n+k) \right] \epsilon^{-j\omega k T} \quad (76)$$

so letting $1 = e^{j\omega nT} e^{-j\omega nT}$

$$S_{N_{xx}}(f) = \frac{1}{N} \left(\sum_{n=-\infty}^{\infty} x(n) e^{j\omega nT} \sum_{k=-\infty}^{\infty} x(n+k) e^{-j\omega(n+k)T} \right) \quad (77)$$

and allowing the variable $m = n + k$

$$S_{N_{xx}}(f) = \frac{1}{N} X_N(f) X_N^*(f) = \frac{1}{N} |X_N(f)|^2 \quad (78)$$

in which the Fourier transform of the signal is

$$X_N(f) = \sum_{n=-\infty}^{\infty} x(n) e^{-j\omega nT} \quad (79)$$

The current discussion leads one to believe that the periodogram is an excellent estimator of the true power spectral density $S(f)$ as N becomes large. This conclusion is false and shortly it will be verified that the periodogram is, in fact, a poor estimate of $S(f)$. To do this, both the expected value and variance of $S_{N_{xx}}(f)$ will be checked for consistency as N becomes large. As a side comment it is generally faster to determine the power spectral density, $S_{N_{xx}}(f)$, of the random process using equation (74) and then inverse Fourier transforming to find $R_{N_{xx}}(k)$ than to obtain $R_{N_{xx}}(k)$ directly. Further, since the periodogram is seen to be the magnitude squared of the Fourier transformed data divided by N , the power spectral density of the random process is unrelated to the angle of the complex Fourier transform $X_N(f)$ of a typical realization.

Prior to checking for the consistency of $S_{N_{xx}}(f)$, the sample autocorrelation must initially be found consistent. Proceeding, since the sample autocorrelation estimate

$$R_{N_{xx}}(k) = \frac{x(0)x(k) + x(1)x(|k|+1) + \dots + x(N-1-|k|)x(N-1)}{N} \quad (80)$$

$$= \frac{1}{N} \sum_{n=0}^{N-1-|k|} x(n)x(n+|k|) \quad (81)$$

$$k = 0, \pm 1, \pm 2, \dots, \pm N - 1$$

which averages together all possible products of samples separated by a lag of k , then, the mean value of the estimate is related to the true autocorrelation function by

$$E[R_{N_{xx}}(k)] = \left(\frac{1}{N} \sum_{n=0}^{N-1-|k|} E[x(n)x(n+|k|)] \right) \quad (82)$$

$$= \frac{N-|k|}{N} R(k)$$

where the true autocorrelation function $R(k)$ is defined as (the sample equivalent of equation A.14-8)

$$R(k) = E[x(n)x(n+k)] \quad (83)$$

From equation (82) it is observed that $R_{N_{xx}}(k)$ is a biased estimator. It is also considered to be asymptotically unbiased since the term

$$\frac{N-|k|}{N}$$

approaches 1 as N becomes large. From these observations $R_{N_{xx}}(k)$ can be classified as a good estimator of $R(k)$. In addition to having a small bias, a good estimator should also have a small variance. The variance of the sample autocorrelation function can thus be computed as

$$\text{var}[R_{N_{xx}}(k)] = E[R_{N_{xx}}^2(k)] - E^2[R_{N_{xx}}(k)] \quad (84)$$

Examining the $E[R_{N_{xx}}(k)]$ term of equation (84), substituting the estimate of equation (81) and replacing n with m , it follows that

$$E[R_{N_{xx}}^2(k)] = E \left\{ \left[\frac{1}{N} \sum_{n=0}^{N-1-|k|} x(n)x(n+|k|) \right] \right. \quad (85)$$

$$\left. \left[\frac{1}{N} \sum_{m=0}^{N-1-|k|} x(m)x(m+|k|) \right] \right\} \\ = \frac{1}{N^2} \left(\sum_{n=0}^{N-1-|k|} \sum_{m=0}^{N-1-|k|} E[x(n)x(n+|k|)x(m)x(m+|k|)] \right) \quad (86)$$

If the statistical assumption that $x(n)$ is a zero-mean Gaussian process, then the zero-mean, jointly Gaussian, random variables symbolized as X_1, X_2, X_3 and X_4 of equation (86) can be described as [Ref. (30)].

$$E[X_1 X_2 X_3 X_4] = E[X_1 X_2] E[X_3 X_4] + E[X_1 X_3] E[X_2 X_4] \\ + E[X_1 X_4] E[X_2 X_3] \quad (87) \\ = \left[E[x(n)x(n+|k|)] E[x(m)x(m+|k|)] \right. \\ \left. + E[x(n)x(m)] E[x(n+|k|)x(m+|k|)] \right. \\ \left. + E[x(n)x(m+|k|)] E[x(n+|k|)x(m)] \right] \quad (88)$$

Using equation (88), equation (84) becomes

$$\text{Var}[R_{N_{xx}}(k)] = \left\{ \frac{1}{N^2} \sum_{n=0}^{N-1-|k|} \sum_{m=0}^{N-1-|k|} \right. \quad (89)$$

$$R_{N_{xx}}(k)R_{N_{xx}}(k) + R_{N_{xx}}(n-m)R_{N_{xx}}(n-m) \\ \left. + R_{N_{xx}}(n-m-|k|)R_{N_{xx}}(n-m+|k|) \right\} \\ - \left[\frac{1}{N} \sum_{n=0}^{N-1-|k|} R_{N_{xx}}(k) \right]^2$$

$$\text{Var}[R_{N_{xx}}(k)] = \frac{1}{N^2} \sum_{n=0}^{N-1-|k|} \sum_{m=0}^{N-1-|k|} \left\{ R_{N_{xx}}^2(n-m) \right. \quad (90) \\ \left. + R_{N_{xx}}(n-m-k)R_{N_{xx}}(n-m+|k|) \right\}$$

where the lag term $n - m$ was obtained from the lag difference between $\tau = n - m = (n + k) - (m + k)$ in the second term of equation (88). The lag term $n - k + m$ and $n - k - m$ was obtained by referencing the third term in equation (88) to n , therefore for

$$E[x(n) x(m + |k|)] \quad (91)$$

the lag term $\tau = n - (m + |k|)$ so

$$E[x(n) x(m + |k|)] = R_{N_{xx}}(n - m + |k|) \quad (92)$$

and for

$$E[x(n + |k|) x(m)] \quad (93)$$

first let $n - m$ then add $|k|$ so $\tau = n - m + |k|$ and

$$E[x(n + |k|) x(m)] = R_{N_{xx}}(n - m + |k|) \quad (94)$$

Recall that a sufficient condition for an estimator to be consistent is that its bias and variance both converge to zero as N becomes infinite. This essentially says that an estimator is consistent if it converges in probability to the true value of the quantity being estimated as N approaches infinity.

Re-examining equation (90), the variance of $R_{N_{xx}}(k)$, and equation (82), the expected value of $R_{N_{xx}}(k)$, it is found that both equations tend toward zero for large N and therefore $R_{N_{xx}}(k)$ is considered as a consistent estimator of $R(k)$ for fixed finite k in practical applications.

Having established that the autocorrelation estimate is consistent, we return to the question of the periodogram consistency.

At first glance, it might seem obvious that $S_{N_{xx}}(f)$ should inherit the asymptotically unbiased and consistent properties of $R_{N_{xx}}(k)$, of which it is a Fourier transform. Unfortunately, however, it will be shown that $S_{N_{xx}}(f)$ does not possess these nice statistical properties.

Going back to the power spectral density of equation (71).

$$S_{N_{xx}}(f) = \sum_{k=-\infty}^{\infty} R_{N_{xx}}(k) \epsilon^{-j\omega kT}$$

and determining its expected value

$$E[S_{N_{xx}}(f)] = \sum_{k=-\infty}^{\infty} E[R_{N_{xx}}(k)] \epsilon^{-j\omega kT} \quad (95)$$

the substitution of equation (82) into equation (95) yields the mean value estimate

$$E[S_{N_{xx}}(f)] = \sum_{K=-N}^N R(k) \left(1 - \frac{|k|}{N}\right) \epsilon^{-j\omega kT} \quad (96)$$

the $\left(1 - \frac{|k|}{N}\right)$

term of equation (96) can be interpreted as $a(k)$, the triangular window resulting from the autocorrelation of finite-sequence rectangular-data window $\omega(k)$ of equation (72). Thus,

$$a(k) = \begin{cases} 1 - \frac{|k|}{N} & |k| < N - 1 \\ 0 & \text{elsewhere} \end{cases} \quad (97a) \quad (97b)$$

and the expected value of the periodogram can be written as the finite sum

$$E[S_{N_{xx}}(f)] = \sum_{k=-\infty}^{\infty} R_{N_{xx}}(k) a(k) \epsilon^{-j\omega kT} \quad (98)$$

Note from equation (98) that the periodogram mean is the discrete Fourier transform of a product of the true autocorrelation function and a triangular window function. This frequency function can be expressed entirely in the frequency domain by the convolution integral. From equation (98), then, the convolution expression for the mean power spectral density is thus,

$$E[S_{N_{xx}}(f)] = \int_{-1/2}^{1/2} S(\eta) A(f - \eta) d\eta \quad (99)$$

where the general frequency expression for the transformed triangular window function $A(f)$ is

$$A(f) = \frac{1}{N} \left[\frac{\sin(2\pi f \frac{N}{2})}{\sin \frac{(2\pi f)}{2}} \right]^2 \quad (100)$$

Re-examining equation (98) or (96) it can be said that equation (71) or (74) gives an asymptotically unbiased estimate of $S(f)$ with the distorting effects of $a(k)$ vanishing as N tends toward infinity. At this point equation (98) still appears as a good estimate of the power spectral density function. For the variance $\text{var}[S_{N_{xx}}(f)]$ however, it can be shown [Ref. (10)] that if the data sequence $x(n)$ comes from a Gaussian process then the variance of $S_{N_{xx}}(f)$ approaches the square of the true spectrum, $S^2(f)$, at each frequency f . Hence, the variance is not small for increasing N ,

$$\lim_{N \rightarrow \infty} \text{var}[S_{N_{xx}}(f)] = S^2(f) \quad (101)$$

More clearly, if the ratio of mean to standard deviation is used as a kind of signal-to-noise ratio, i.e.

$$\frac{E[S_{N_{xx}}(f)]}{\{\text{var}[S_{N_{xx}}(f)]\}^{1/2}} \approx \frac{S(f)}{S(f)} = 1 \quad (102)$$

it can be seen that the true signal spectrum is only as large as the noise or uncertainty in $S_{N_{xx}}(f)$ for increasing N . In addition, the variance of equation (101), which also is approximately applicable for non-Gaussian sequences, indicates that calculations using different sets of N samples from the same $x(n)$ process will yield vastly different values of $S_{N_{xx}}(f)$ even when N becomes large. Unfortunately, since the variance of $S_{N_{xx}}(f)$ does not decrease to zero as N approaches infinity, the periodogram is thus an inconsistent estimate of the power spectral density and cannot be used for spectrum analysis in its present form.

7.0 SPECTRAL ESTIMATION BY AVERAGING PERIODOGRAMS

It was shown in the last section that the periodogram was not a consistent estimate of the power spectral density

function. A technique introduced by Bartlett, however, allows the use of the periodogram and, in fact, produces a consistent spectral estimation by averaging periodograms. In short, Bartlett's approach reduces the variance of the estimates by averaging together several independent periodograms. If, for example $X_1, X_2, X_3, \dots, X_L$ are uncorrelated random variables having an expected value $E[x]$ and a variance σ^2 , then the arithmetic mean

$$\frac{X_1 + X_2 + X_3 + \dots + X_L}{L} \quad (103)$$

has the expected value $E[x]$ and a variance of σ^2/L . This fact suggests that a spectral estimator can have its variance reduced by a factor of L over the periodogram. The procedure requires the observed process, an N point data sequence, to be split up into L nonoverlapping M point sections and then averaging the periodograms of each individual section.

To be more specific, dividing an N point data sequence $x(n)$, $0 \leq n \leq N - 1$, into L segments of M samples each the segments $X_M^\ell(n)$ are formed. Thus,

$$x_M^\ell(n) = x(n + \ell M - M) \quad \begin{cases} 0 \leq n \leq M - 1 \\ 1 \leq \ell \leq L \end{cases} \quad (104)$$

where the superscript ℓ specifies the segment or interval of data being observed, the subscript M represents the number of data points or samples per segment and depending upon the choice of L and M , we have $N \geq LM$. For the computation of L periodograms

$$S_M^\ell(f) = \left| \frac{1}{M} \sum_{n=0}^{M-1} x_M^\ell(n) e^{-j\omega n T} \right|^2 \quad 1 \leq \ell \leq L \quad (105)$$

If the autocorrelation function $R_{N_{xx}}(m)$ becomes negligible for m large relative to M , $m > M$, then it can be said that the periodograms of the separate sections are virtually independent of one another. The corresponding *averaged periodogram estimator* $\hat{S}_M^\ell(f)$ computed from L individual periodograms of length M is thus defined

$$\hat{S}_M^\ell(f) = \frac{1}{L} \sum_{\ell=1}^L S_M^\ell(f) \quad (106)$$

Since the L subsidiary estimates are identically distributed periodograms, the averaged spectral estimate will have the same mean or expected value as any of the subsidiary estimates so

$$E[\hat{S}_M^\ell(f)] = \frac{1}{L} \sum_{\ell=1}^L E[S_M^\ell(f)] \quad (107)$$

$$= E[S_M^\ell(f)] \quad (108)$$

From this, the expected value of the Bartlett estimate can be said to be the convolution of the true spectral density with the Fourier transform of the triangular window function corresponding to the M sample periodogram where $M \leq N/L$ equations (98) or (99) we see that

$$E[\hat{S}_M^\ell(f)] = E[S_M^\ell(f)] = \frac{1}{M} \int_{-1/2}^{1/2} S(\eta) A(f - \eta) d\eta \quad (109)$$

where $A(f)$ is the Fourier transformed triangular window function of equation (100). Though the averaged estimate is no different than before, its variance, however, is smaller. Recall that the variance of the average of L identical independent random variables is $1/L$ of the individual variances, equation (51). Thus, for L statistically independent periodograms, the variance of the averaged estimate is

$$\text{var}[\hat{S}_M^\ell(f)] = \frac{1}{L} \text{var}[S_{N_{xx}}(f)] \cong \frac{1}{L} [S(f)]^2 \quad (110)$$

So, again, the averaging of L periodograms results in approximately a factor of L reduction in power spectral density estimation variance. Since the variance of equation (110) tends to zero as L approaches infinity and through equation (98) and (99) $\hat{S}_M^\ell(f)$ is asymptotically unbiased, $\hat{S}_M^\ell(f)$ can be said to be a consistent estimate of the true spectrum.

A few notes are next in order. First, the L fold variance reduction or $(L)^{1/2}$ signal-to-noise ratio improvement of equation (102) is not precisely accurate since there is some dependence between the subsidiary periodograms. The adjacent samples will be correlated unless the process being analyzed is white.

However, as indicated in equation (110), such a dependence will be small when there are many sample intervals per periodogram so that the reduced variance is still a good approximation. Secondly, the bias of $\hat{S}_M^\ell(f)$, equation (106), is greater than $\hat{S}_M^\ell(f)$, equation (105), since the main lobe of the spectral window is larger for the former. For this situation, then, the bias can be thought of as effecting spectral resolution. It is seen that increasing the number of periodograms for a fixed record length N decreases not only the variance but, the samples per periodograms M decrease also. This decreases the spectral resolution. Thus when using the Bartlett procedure the actual choice of M and N will typically be selected from prior knowledge of a signal or data sequence under consideration. The tradeoff, however, will be between the spectral resolution of bias and the variance of the estimate.

8.0 WINDOWS

Prior to looking at other techniques of spectrum estimation, we find that to this point the subject of spectral windows has been brought up several times during the course of our discussion. No elaboration, however, has been spent explaining their spectral effects and meaning. It is thus appropriate at this juncture to diverge for a short while to develop a fundamental understanding of windows and their spectral implications prior to the discussion of Sections 9 and 10 (for an in depth study of windows see *Windows, Harmonic Analysis and the Discrete Fourier Transform*; Frederic J. Harris; submitted to IEEE Proceedings, August 1976).

In most applications it is desirable to taper a finite length data sequence at each end to enhance certain characteristics of the spectral estimate. The process of terminating a sequence after a finite number of terms can be thought of as multiplying an infinite length, i.e., impulse response sequence by a finite width window function. In other words, the window function determines how much of the original impulse sequence can be observed through this window,

see Figures 4a, 4b, and 4c. This tapering by multiplying the sequence by a data window is thus analogous to multiplying the correlation function by a lag window. In addition, since multiplication in the time domain is equivalent to convolution in the frequency domain then it is also analogous to convolving the Fourier transform of a finite-length-sequence with the Fourier transform of the window function, Figures 4d, 4e, and 4f. Note also that the Fourier transform of the rectangular window function exhibits significant oscillations and poor high frequency convergence, Figure 4e. Thus, when convolving this spectrum with a desired amplitude function, poor convergence of the resulting amplitude response may occur. This calls for investigating the use of other possible window functions that minimize some of the difficulties encountered with rectangular function.

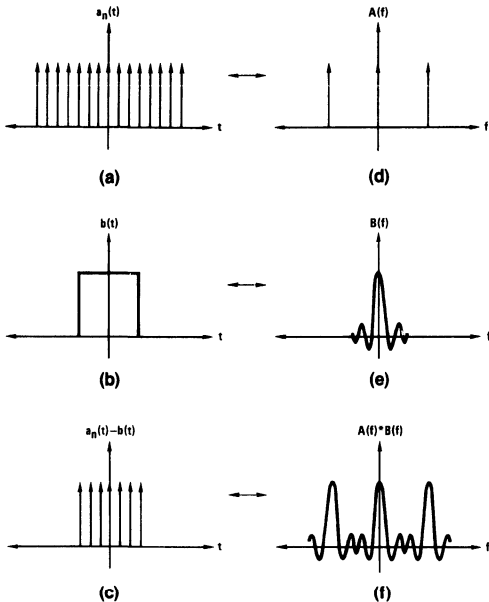


FIGURE 4

In order for the spectrum of a window function to have minimal effects upon the desired amplitude response, resulting from convolving two functions, it is necessary that the window spectrum approximate an impulse function. This implies that as much of its energy as possible should be concentrated at the center of the spectrum. Clearly, an ideal impulse spectrum is not feasible since this requires an infinitely long window.

In general terms, the spectrum of a window function typically consists of a main lobe, representing the center of the spectrum, and various side lobes, located on either side of the main lobe (see Figures 6 thru 9). It is desired that the window function satisfy two criteria; (1) that the main lobe should be as narrow as possible and (2) relative to the

main lobe, the maximum side lobe level should be as small as possible. Unfortunately, however, both conditions cannot be simultaneously optimized so that, in practice, usable window functions represent a suitable compromise between the two criteria. A window function in which minimization of the main lobe width is the primary objective, fields a finer frequency resolution but suffers from some oscillations, i.e., the spectrum passband and substantial ripple in the spectrum stopband. Conversely, a window function in which minimization of the side lobe level is of primary concern tends to have a smoother amplitude response and very low ripple in the stopband but, yields a much poorer frequency resolution. Examining Figure 5 assume a hypothetical impulse response, Figure 5a, whose spectrum is Figure 5b. Multiplying the impulse response by the rectangular window, Figure 4b, yields the windowed impulse response, Figure 5c, implying the convolution of the window spectrum, Figure 4e, with the impulse response spectrum, Figure 5b. The result of this convolution is seen in Figure 5d and is a distorted version of the ideal spectrum, Figure 5b, having passband oscillations and stopband ripple. Selecting another window, i.e., Figure 9 with more desirable spectral characteristics, we see the appropriately modified windowed data, Figure 5e, results in a very good approximation of Figure 5b.

This characteristicly provides a smoother passband and lower stopband ripple level but sacrifices the sharpness of the roll-off rate inherent in the use of a rectangular window (compare Figures 5d and 5f). Concluding this brief discussion, a few common window functions will next be considered.

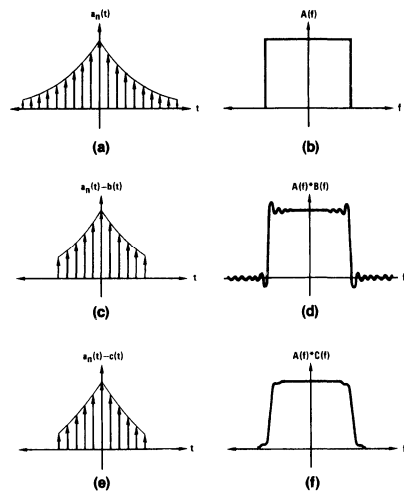


FIGURE 5. (a)(b) Unmodified Data Sequence
(c)(d) Rectangular Windowed Data Sequence
(e)(f) Hamming Windowed Data Sequence

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Rectangular window: *Figure 6*

$$w(n) = 1 \quad |n| < \frac{N-1}{2} \quad (111)$$

$$= 0 \quad \text{otherwise}$$

Bartlett or triangular window: *Figure 7*

$$w(n) = 1 - \frac{2|n|}{N} \quad |n| < \frac{N-1}{2} \quad (112)$$

$$= 0 \quad \text{otherwise}$$

Hann window: *Figure 8*

$$w(n) = 0.5 + 0.5 \cos\left(\frac{2\pi n}{N}\right) \quad |n| < \frac{N-1}{2} \quad (113)$$

$$= 0 \quad \text{otherwise}$$

Hamming window: *Figure 9*

$$w(n) = 0.54 + 0.46 \cos\left(\frac{2\pi n}{N}\right) \quad |n| < \frac{N-1}{2} \quad (114)$$

$$= 0 \quad \text{otherwise}$$

Again the reference previously cited should provide a more detailed window selection. Nevertheless, the final window choice will be a compromise between spectral resolution and passband (stopband) distortion.

9.0 SPECTRAL ESTIMATION BY USING WINDOWS TO SMOOTH A SINGLE PERIODOGRAM

It was seen in a previous section that the variance of a power spectral density estimate based on an N point data sequence could be reduced by chopping the data into shorter segments and then averaging the periodograms of the individual segments. This reduced variance was acquired at the expense of increased bias and decreased spectral resolution. We will cover in this section an alternate way of computing a reduced variance estimate using a smoothing operation on the single periodogram obtained from the entire N point data sequence. In effect, the periodogram is smoothed by convolving it with an appropriate spectral window. Hence if $S_{XX}(f)$ denotes the smooth periodogram then,

$$S_{W_{XX}}(f) = \int_{-1/2}^{1/2} S_{N_{XX}}(\eta) W(f-\eta) d\eta = S_{N_{XX}}(\eta) * W(\eta) \quad (115)$$

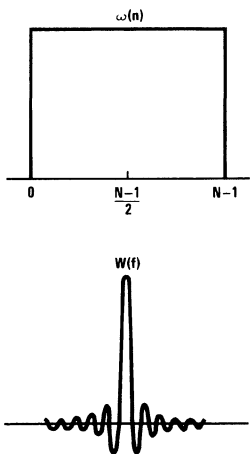


FIGURE 6. Rectangular Window

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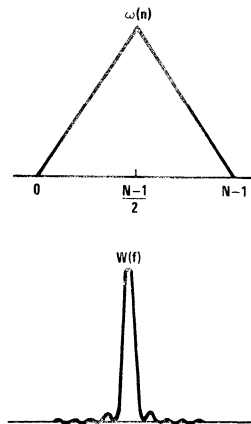


FIGURE 8. Hann Window

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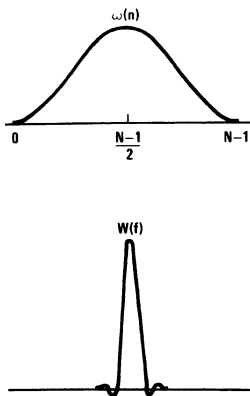


FIGURE 7. Bartlett or Triangular Window

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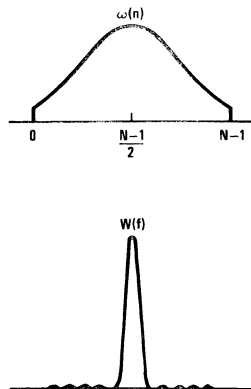


FIGURE 9. Hamming Window

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where $W(f - \eta)$ is the spectral window and $*$ denotes convolution. Since the periodogram is equivalent to the Fourier transform of the autocorrelation function $R_{N_{xx}}(k)$ then, using the frequency convolution theorem

$$F\{x(t)y(t)\} = X(f) * Y(f - \eta) \quad (116)$$

where $F\{\}$ denotes a Fourier transform, $S_{xx}(f)$ is the Fourier transform of the product of $R_{N_{xx}}(k)$ and the inverse Fourier transform of $W(f)$. Therefore for a finite duration window sequence of length $2K - 1$,

$$S_{W_{xx}}(f) = \sum_{k=-(K-1)}^{K-1} R_{N_{xx}}(k) w(k) e^{-j\omega k T} \quad (117)$$

where

$$w(k) = \sum_{-1/2}^{1/2} W(f) e^{j\omega k T} df \quad (118)$$

References (10)(16)(21) proceed further with a development to show that the smoothed single windowed periodogram is a consistent estimate of the power spectral density function. The highlights of the development, however, show that a smoothed or windowed spectral estimate, $S_{W_{xx}}(f)$, can be made to have a smaller variance than that of the straight periodogram, $S_{N_{xx}}(f)$, by β the variance ratio relationship

$$\beta = \frac{\text{var}[S_{W_{xx}}(f)]}{\text{var}[S_{N_{xx}}(f)]} = \frac{1}{N} \sum_{m=-(M-1)}^{M-1} w^2(m) \quad (119)$$

$$= \frac{1}{N} \int_{-1/2}^{1/2} W^2(f) df$$

where N is the record length and $2M - 1$ is the total window width. Note that the energy of the window function can be found in equation (119) as

$$E_w = \sum_{m=-(M-1)}^{M-1} w^2(m) = \int_{-1/2}^{1/2} W^2(f) df \quad (120)$$

Continuing from equation (119), it is seen that a satisfactory estimate of the periodogram requires the variance of $S_{W_{xx}}(f)$ to be small compared to $S_{N_{xx}}^2$ so that

$$\beta \ll 1 \quad (121)$$

Therefore, it is the adjusting of the length and shape of the window that allows the variance of $S_{W_{xx}}(f)$ to be reduced over the periodogram.

Smoothing is like a low pass filtering effect, and so, causes a reduction in frequency resolution. Further, the width of the window main lobe, defined as the symmetric interval between the first positive and negative frequencies at which $W(f) = 0$, in effect determines the bandwidth of the smoothed spectrum. Examining Table I for the following defined windows;

Rectangular window

$$w(m) = 1 \quad |m| \leq M - 1 \quad (122)$$

$$= 0 \quad \text{otherwise}$$

Bartlett or triangular window

$$w(m) = 1 - \frac{|m|}{M} \quad |m| \leq M - 1 \quad (123)$$

$$= 0 \quad \text{otherwise}$$

Hann window

$$w(m) = 0.5 + 0.5 \cos\left(\frac{\pi m}{M - 1}\right) \quad |m| \leq M - 1 \quad (124)$$

$$= 0 \quad \text{otherwise}$$

Hamming window

$$w(m) = 0.54 + 0.46 \cos\left(\frac{\pi m}{M - 1}\right) \quad |m| \leq M - 1 \quad (125)$$

$$= 0 \quad \text{otherwise}$$

We see once again, as in the averaging technique of spectral estimation (Section 7), the smoothed periodogram technique of this discussion also makes a trade-off between variance and resolution for a fixed N . A small variance requires a small M while high resolution requires a large M .

TABLE I

Window Function	Width of Main Lobe* (approximate)	Variance Ratio* (approximate)
Rectangular	$\frac{2\pi}{M}$	$\frac{2M}{N}$
Bartlett	$\frac{4\pi}{M}$	$\frac{2M}{3N}$
Hann	$\frac{3\pi}{M}$	$2M \left[\frac{(0.5)^2 + (0.5)^2}{2N} \right]$
Hamming	$\frac{3\pi}{M}$	$2M \left[\frac{(0.54)^2 + (0.46)^2}{2N} \right]$

*Assumes $M > 1$

10.0 SPECTRAL ESTIMATION BY AVERAGING MODIFIED PERIODOGRAMS

Welch [Ref. (36)(37)] suggests a method for measuring power spectra which is effectively a modified form of Bartlett's method covered in Section 7. This method, however, applies the window $w(n)$ directly to the data segments before computing their individual periodograms. If the data sequence is sectioned into

$$L \leq \frac{N}{M}$$

segments of M samples each as defined in equation (104), the L modified or windowed periodogram can be defined as

$$I_M^\ell(f) = \frac{1}{UM} \left| \sum_{n=0}^{M-1} x_M^\ell(n) w(n) e^{-j\omega n T} \right|^2 \quad 1 \leq \ell \leq L \quad (126)$$

where U , the energy in the window is

$$U = \frac{1}{M} \sum_{n=0}^{M-1} w^2(n) \quad (127)$$

Note the similarity between equations (126) and (105) and that equation (126) is equal to equation (105) modified by functions of the data window $w(n)$.

The spectral estimate \hat{I}_M^ℓ is defined as

$$\hat{I}_M^\ell(f) = \frac{1}{L} \sum_{\ell=1}^L I_M^\ell(f) \quad (128)$$

and its expected value is given by

$$E[\hat{I}_M^\ell(f)] = \int_{-1/2}^{1/2} S_{N_{xx}}(\eta) W(f-\eta) d\eta = S_{N_{xx}}(f) W(f) \quad (129)$$

where

$$W(f) = \frac{1}{UM} \left| \sum_{n=0}^{M-1} w(n) e^{-j\omega n T} \right|^2 \quad (130)$$

The normalizing factor U is required so that the spectral estimate $\hat{I}_M^\ell(f)$, of the modified periodogram, $I_M^\ell(f)$, will be asymptotically unbiased [Ref. (34)]. If the intervals of $x(n)$ were to be nonoverlapping, then Welch [Ref. (37)] indicates that

$$\text{var}[\hat{I}_M^\ell(f)] \cong \frac{1}{L} \text{var}[S_{N_{xx}}(f)] \cong \frac{1}{L} [S(f)]^2 \quad (131)$$

which is similar to that of equation (110). Also considered is a case where the data segments overlap. As the overlap increases the correlation between the individual periodograms also increases. We see further that the number of M point data segments that can be formed increases. These two effects counteract each other when considering the variance $I_M^\ell(f)$. With a good data window, however, the increased number of segments has the stronger effect until the overlap becomes too large. Welch has suggested that a 50 percent overlap is a reasonable choice for reducing the variance when N is fixed and cannot be made arbitrarily large. Thus, along with windowing the data segments prior to computing their periodograms, achieves a variance reduction over the Bartlett technique and at the same time smooths the spectrum at the cost of reducing its resolution. This trade-off between variance and spectral resolution or bias is an inherent property of spectrum estimators.

11.0 PROCEDURES FOR POWER SPECTRAL DENSITY ESTIMATES

Smoothed single periodograms [Ref. (21)(27)(32)]

- A. 1. Determine the sample autocorrelation $R_{N_{xx}}(k)$ of the data sequence $x(n)$
2. Multiply $R_{N_{xx}}(k)$ by an appropriate window function $w(n)$
3. Compute the Fourier transform of the product

$$R_{N_{xx}}(k) w(n) \longleftrightarrow S_{W_{xx}}(f) \quad (71)$$

- B. 1. Compute the Fourier transform of the data sequence $x(n)$

$$x(n) \longleftrightarrow X(f)$$

2. Multiply $X(f)$ by its conjugate to obtain the power spectral density $S_{N_{xx}}(f)$

$$S_{N_{xx}}(f) = \frac{1}{N} |X(f)|^2 \quad (74)$$

3. Convolve $S_{N_{xx}}(f)$ with an appropriate window function $W(f)$

$$S_{W_{xx}}(f) = S_{N_{xx}}(f) * W(f) \quad (115)$$

- C. 1. Compute the Fourier transform of the data sequence $x(n)$

$$x(n) \longleftrightarrow X(f)$$

2. Multiply $X(f)$ by its conjugate to obtain the power spectral density $S_{N_{xx}}(f)$

$$S_{N_{xx}}(f) = \frac{1}{N} |X(f)|^2 \quad (74)$$

3. Inverse Fourier transform $S_{N_{xx}}(f)$ to get $R_{N_{xx}}(k)$
4. Multiply $R_{N_{xx}}(k)$ by an appropriate window function $w(n)$
5. Compute the Fourier transform of the product to obtain $S_{W_{xx}}(f)$

$$S_{W_{xx}}(f) \longleftrightarrow R_{N_{xx}}(k) * w(n) \quad (117)$$

Averaging periodograms [Ref. (32)(37)(38)]

- A. 1. Divide the data sequence $x(n)$ into $L \leq N/M$ segments, $x_M^\ell(n)$
2. Multiply a segment by an appropriate window
3. Take the Fourier transform of the product
4. Multiply procedure 3 by its conjugate to obtain the spectral density of the segment
5. Repeat procedures 2 through 4 for each segment so that the average of these periodogram estimates produce the power spectral density estimate, equation (128)

12.0 RESOLUTION

In analog bandpass filters, resolution is defined by the filter bandwidth, Δf_{BW} , measured at the passband half power points. Similarly, in the measurement of power spectral density functions it is important to be aware of the resolution capabilities of the sampled data system. For such a system resolution is defined as

$$\Delta f_{BW} = \frac{1}{NT} \quad (132)$$

and for;

$$\text{Correlation resolution} \quad \tau_{\max} = mT, \text{ where } m \quad (133)$$

$$\Delta f_{BW} = \frac{1}{\tau_{\max}}$$

is the maximum value allowed to produce τ_{\max} , the maximum lag term in the correlation computation

Fourier transform (FFT) resolution

$$\Delta f_{BW} = \frac{1}{P_L} = \frac{m}{NT} = \frac{1}{LT} \quad \text{where } P \text{ is the record length, } N, \text{ the number of data points and } m, \text{ the samples within each } L \text{ segment,}$$

$$L = \frac{N}{M} \quad (134)$$

Note that the above Δf_{BW} 's can be substantially poorer depending upon the choice of the data window. A loss in degrees of freedom (Section 13) and statistical accuracy occurs when a data sequence is windowed. That is, data at each end of a record length are given less weight than the data at the middle for anything other than the rectangular window. This loss in degrees of freedom shows up as a loss in resolution because the main lobe of the spectral window is widened in the frequency domain.

Finally, the limits of a sampled data system can be described in terms of the maximum frequency range and minimum frequency resolution. The maximum frequency range is the Nyquist or folding frequency, f_c ,

$$f_c = \frac{f_s}{2} = \frac{1}{2T_s} \quad (135)$$

where f_s is the sampling frequency and T_s the sampling period. And, secondly, the resolution limit can be described in terms of a $(\Delta f_{BW}) NT$ product where

$$\Delta f_{BW} \geq \frac{1}{NT} \quad (136)$$

or

$$(\Delta f_{BW}) NT \geq 1 \quad (137)$$

13.0 CHI-SQUARE DISTRIBUTIONS

Statistical error is the uncertainty in power spectral density measurements due to the amount of data gathered, the probabilistic nature of the data and the method used in deriving the desired parameter. Under reasonable conditions the spectral density estimates approximately follow a chi-square, χ_n^2 , distribution. χ_n^2 is defined as the sum of the squares of χ_{n-1} , $1 \leq n \leq N$, independent Gaussian variables each with a zero mean and unit variance such that

$$\chi_N^2 = \sum_{n=1}^N \chi_n^2 \quad (138)$$

The number n is called the *degrees of freedom* and the χ_n^2 probability density function is

$$f(\chi_n^2) = \frac{1}{2^{n/2} \Gamma(\frac{n}{2})} \left[(\chi_n^2)^{\frac{n-2}{2}} \right] e^{-\frac{\chi_n^2}{2}} \quad (139)$$

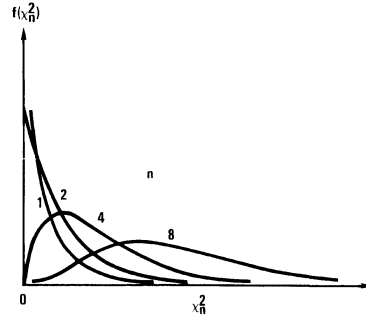
where $\Gamma(\frac{n}{2})$ is the statistical gamma function (Ref. (14)).

Figure 10 shows the probability density function for several n values and it is important to note that as n becomes large the chi-square distribution approximates a Gaussian distribution. We use this χ_n^2 distribution in our analysis to discuss the variability of power spectral densities. If x_n has a zero mean and N samples of it are used to compute the power spectral density estimate $S(f)$ then, the probability that the true spectral density, $S(f)$, lies between the limits

$$A \leq S(f) \leq B \quad (140)$$

is

$$P = (1 - \alpha) = \text{probability} \quad (141)$$



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FIGURE 10

The lower A and upper B limits are defined as

$$A = \frac{n\hat{S}(f)}{\chi_{n, \frac{\alpha}{2}}^2} \quad (142)$$

and

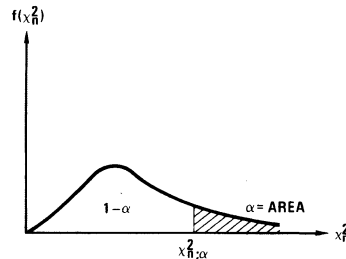
$$B = \frac{n\hat{S}(f)}{\chi_{n, 1 - \frac{\alpha}{2}}^2} \quad (143)$$

respectively. $\chi_{n, \alpha}^2$ is defined by

$$\chi_{n, \alpha}^2 = [\nu \text{ so that } \int_{\nu}^{\infty} f(\chi_n^2) d\chi_n^2 = \alpha] \quad (144)$$

see Figure 11 and the interval A to B is referred to as a confidence interval. From Otnes and Enrochson [Ref. (35) pg. 217] the degrees of freedom can be described as

$$n = 2(\Delta f_{BW}) NT = 2(\Delta f_{BW}) P_L \quad (145)$$



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FIGURE 11

and that for large n i.e., $n \geq 30$ the χ_n^2 distribution approaches a Gaussian distribution so that the standard deviation or standard error, ϵ_o , can be given by

$$\epsilon_o = \frac{1}{\sqrt{\Delta f_{BW} NT}} \quad (146)$$

The degrees of freedom and associated standard error for the correlation and Fourier transform are as follows:

$$\text{correlation: } n = \frac{2N}{m} \quad \epsilon_o = \sqrt{\frac{m}{N}} \quad (147)$$

$$\text{FFT: } n = 2M \quad \epsilon_o = \sqrt{\frac{1}{M}} \quad (148)$$

where M is the number of $|X(f)|^2$ values

$$M = NT (\Delta f_{BW})_{\text{desired}} \quad (149)$$

and m is the maximum lag value.

An example will perhaps clarify the usage of this information.

Choosing $T = 100$ ms, $N = 8000$ samples and $n = 20$ degrees of freedom then

$$f_c = \frac{1}{2T} = 5 \text{ Hz}$$

$$n = 2(NT) (\Delta f_{BW})$$

so

$$\Delta f_{BW} = \frac{n}{2NT} = 0.0125 \text{ Hz}$$

If it is so desired to have a 95% confidence level of the spectral density estimate then

$$P = (1 - \alpha)$$

$$0.95 = 1 - \alpha$$

$$\alpha = 1 - 0.95 = 0.05$$

the limits

$$B = \frac{n \hat{S}(f)}{\chi_{n; 1 - \alpha/2}^2} = \frac{20 \hat{S}(f)}{\chi_{20; 0.975}^2}$$

$$A = \frac{n \hat{S}(f)}{\chi_{n; \alpha/2}^2} = \frac{20 \hat{S}(f)}{\chi_{20; 0.025}^2}$$

yield from Table II

$$\chi_{20; 0.975}^2 = 9.59$$

$$\chi_{20; 0.025}^2 = 34.17$$

so that

$$\frac{20 \hat{S}(f)}{34.17} \leq S(f) \leq \frac{20 \hat{S}(f)}{9.59}$$

$$0.5853 \hat{S}(f) \leq S(f) \leq 2.08 \hat{S}(f)$$

There is thus a 95% confidence level that the true spectral density function $S(f)$ lies within the interval $0.5853 \hat{S}(f) \leq S(f) \leq 2.08 \hat{S}(f)$.

As a second example using equation (148) let $T = 1$ ms, $N = 4000$ and it is desired to have $(\Delta f_{BW})_{\text{desired}} = 10$ Hz.

Then,

$$NT = 4$$

$$f_c = \frac{1}{2T} = 500 \text{ Hz}$$

$$\epsilon_o = \sqrt{\frac{1}{M}} = \sqrt{\frac{1}{NT (\Delta f_{BW})_{\text{desired}}}} = 0.158$$

$$N = 2M = 2NT (\Delta f_{BW})_{\text{desired}} = 80$$

If it is again desired to have a 95% confidence level of the spectral density estimate then

$$\alpha = 1 - p = 0.05$$

$$\chi_{80; 0.975}^2 = 5.75$$

$$\chi_{80; 0.025}^2 = 106.63$$

and we thus have a 95% confidence level that the true spectral density $S(f)$ lies within the limits

$$0.75 \hat{S}(f) \leq S(f) \leq 1.39 \hat{S}(f)$$

It is important to note that the above examples assume Gaussian and white data. In practical situations the data is typically colored or correlated and effectively results in reducing number of degrees of freedom. It is best, then, to use the white noise confidence levels as guidelines when planning power spectral density estimates.

14.0 CONCLUSION

This article attempted to introduce to the reader a conceptual overview of power spectral estimation. In doing so a wide variety of subjects were covered and it is hoped that this approach left the reader with a sufficient base of "tools" to indulge in the mounds of technical literature available on the subject.

15.0 ACKNOWLEDGEMENTS

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TABLE II. Percentage Points of the Chi-Square Distribution

n	α							
	0.995	0.990	0.975	0.950	0.050	0.025	0.010	0.005
1	0.000039	0.00016	0.00098	0.0039	3.84	5.02	6.63	7.88
2	0.0100	0.0201	0.0506	0.1030	5.99	7.38	9.21	10.60
3	0.0717	0.115	0.216	0.352	7.81	9.35	11.34	12.84
4	0.207	0.297	0.484	0.711	9.49	11.14	13.28	14.86
5	0.412	0.554	0.831	1.150	11.07	12.83	15.09	16.75
6	0.68	0.87	1.24	1.64	12.59	14.45	16.81	18.55
7	0.99	1.24	1.69	2.17	14.07	16.01	18.48	20.28
8	1.34	1.65	2.18	2.73	15.51	17.53	20.09	21.96
9	1.73	2.09	2.70	3.33	16.92	19.02	21.67	23.59
10	2.16	2.56	3.25	3.94	18.31	20.48	23.21	25.19
11	2.60	3.05	3.82	4.57	19.68	21.92	24.72	26.76
12	3.07	3.57	4.40	5.23	21.03	23.34	26.22	28.30
13	3.57	4.11	5.01	5.89	22.36	24.74	27.69	29.82
14	4.07	4.66	5.63	6.57	23.68	26.12	29.14	31.32
15	4.60	5.23	6.26	7.26	25.00	27.49	30.58	32.80
16	5.14	5.81	6.91	7.96	26.30	28.85	32.00	34.27
17	5.70	6.41	7.56	8.67	27.59	30.19	33.41	35.72
18	6.26	7.01	8.23	9.39	28.87	31.53	34.81	37.16
19	6.84	7.63	8.91	10.12	30.14	32.85	36.19	38.58
20	7.43	8.26	9.59	10.85	31.41	34.17	37.57	40.00
21	8.03	8.90	10.28	11.59	32.67	35.48	38.93	41.40
22	8.64	9.54	10.98	12.34	33.92	36.78	40.29	42.80
23	9.26	10.20	11.69	13.09	35.17	38.08	41.64	44.18
24	9.89	10.86	12.40	13.85	36.42	39.36	42.98	45.56
25	10.52	11.52	13.12	14.61	37.65	40.65	44.31	46.93
26	11.16	12.20	13.84	15.38	38.89	41.92	45.64	48.29
27	11.81	12.88	14.57	16.15	40.11	43.19	46.96	49.64
28	12.46	13.56	15.31	16.93	41.34	44.46	48.28	50.99
29	13.12	14.26	16.05	17.71	42.56	45.72	49.59	52.34
30	13.79	14.95	16.79	18.49	43.77	46.98	50.89	53.67
40	20.71	22.16	24.43	26.51	55.76	59.34	63.69	66.77
50	27.99	29.71	32.36	34.76	67.50	71.42	76.15	79.49
60	35.53	37.48	40.48	43.19	79.08	83.80	88.38	91.95
70	43.28	45.44	48.76	51.74	90.53	95.02	100.43	104.22
80	51.17	53.54	57.15	60.39	101.88	106.63	112.33	116.32
90	59.20	61.75	65.65	69.13	113.14	118.14	124.12	128.30
100	67.33	70.06	74.22	77.93	124.34	129.56	135.81	140.17

APPENDIX A

A.0 CONCEPTS OF PROBABILITY, RANDOM VARIABLES AND STOCHASTIC PROCESSES

In many physical phenomena the outcome of an experiment may result in fluctuations that are random and cannot be precisely predicted. It is impossible, for example, to determine whether a coin tossed into the air will land with its head side or tail side up. Performing the same experiment over a long period of time would yield data sufficient to indicate that on the average it is equally likely that a head or tail will turn up. Studying this average behavior of events allows one to determine the frequency of occurrence of the outcome (i.e., heads or tails) and is defined as the notion of *probability*.

Associated with the concept of probability are probability density functions and cumulative distribution functions which find their use in determining the outcome of a large number of events. A result of analyzing and studying these functions may indicate regularities enabling certain laws to be determined relating to the experiment and its outcomes; this is essentially known as *statistics*.

A.1 DEFINITIONS OF PROBABILITY

If n_A is the number of times that an event A occurs in N performances of an experiment, the frequency of occurrence of event A is thus the ratio n_A/N . Formally, the probability, $P(A)$, of event A occurring is defined as

$$P(A) = \lim_{N \rightarrow \infty} \left[\frac{n_A}{N} \right] \quad (\text{A.1-1})$$

Where it is seen that the ratio n_A/N (or fraction of times that an event occurs) asymptotically approaches some mean value (or will show little deviation from the exact probability) as the number of experiments performed, N, increases (more data).

Assigning a number,

$$\frac{n_A}{N},$$

to an event is a measure of how likely or probable the event.

Since n_A and N are both positive and real numbers and $0 \leq n_A \leq N$; it follows that the probability of a given event cannot be less than zero or greater than unity. Furthermore, if the occurrence of any one event excludes the occurrence of any others (i.e., a head excludes the occurrence of a tail in a coin toss experiment), the possible events are said to be *mutually exclusive*. If a complete set of possible events A_1 to A_n are included then

$$\frac{n_{A_1}}{N} + \frac{n_{A_2}}{N} + \frac{n_{A_3}}{N} + \dots + \frac{n_{A_n}}{N} = 1 \quad (\text{A.1-2})$$

or

$$P(A_1) + P(A_2) + P(A_3) + \dots + P(A_n) = 1 \quad (\text{A.1-3})$$

Similarly, an event that is absolutely certain to occur has a probability of one and an impossible event has a probability of zero.

In summary:

1. $0 \leq P(A) \leq 1$
2. $P(A_1) + P(A_2) + P(A_3) + \dots + P(A_n) = 1$, for an entire set of events that are mutually exclusive
3. $P(A) = 0$ represents an impossible event
4. $P(A) = 1$ represents an absolutely certain event

A.2 JOINT PROBABILITY

If more than one event at a time occurs (i.e., events A and B are not mutually exclusive) the frequency of occurrence of the two or more events at the same time is called the *joint probability*, $P(AB)$. If n_{AB} is the number of times that event A and B occur together in N performances of an experiment, then

$$P(A,B) = \lim_{N \rightarrow \infty} \left[\frac{n_{AB}}{N} \right] \quad (\text{A.2-1})$$

A.3 CONDITIONAL PROBABILITY

The probability of event B occurring given that another event A has already occurred is called *conditional probability*. The dependence of the second, B, of the two events on the first, A, will be designated by the symbol $P(B|A)$ or

$$P(B|A) = \frac{n_{AB}}{n_A} \quad (\text{A.3-1})$$

where n_{AB} is the number of joint occurrences of A and B and n_A represents the number of occurrences of A with or without B. By dividing both the numerator and denominator of equation (A.3-1) by N, conditional probability $P(B|A)$ can be related to joint probability, equation (A.2-1), and the probability of a single event, equation (A.1-1)

$$P(B|A) = \left(\frac{n_{AB}}{n_A} \right) \left(\frac{\frac{1}{N}}{\frac{1}{N}} \right) = \frac{P(A,B)}{P(A)} \quad (\text{A.3-2})$$

Analogously

$$P(A|B) = \frac{P(A,B)}{P(B)} \quad (\text{A.3-3})$$

and combining equations (A.6) and (A.7)

$$P(A|B) P(B) = P(A, B) = P(B|A) P(A) \quad (\text{A.3-4})$$

results in Bayes' theorem

$$P(A|B) = \frac{P(A) P(B|A)}{P(B)} \quad (\text{A.3-5})$$

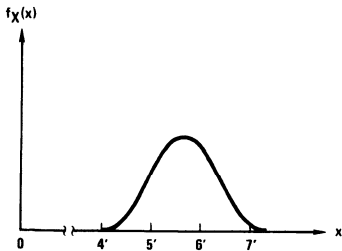
Using Bayes' theorem, it is realized that if P(A) and P(B) are *statistically independent* events, implying that the probability of event A does not depend upon whether or not event B has occurred, then $P(A|B) = P(A)$, $P(B|A) = P(B)$ and hence the joint probability of events A and B is the product of their individual probabilities or

$$P(A,B) = P(A) P(B) \quad (A.3-6)$$

More precisely, two random events are statistically independent only if equation (A.3-6) is true.

A.4 PROBABILITY DENSITY FUNCTIONS

A formula, table, histogram, or graphical representation of the probability or possible frequency of occurrence of an event associated with variable X, is defined as $f_X(x)$, the *probability density function* (pdf) or *probability distribution function*. As an example, a function corresponding to height histograms of men might have the probability distribution function depicted in *Figure A.4.1*.



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FIGURE A.4.1

The *probability element*, $f_X(x) dx$, describes the probability of the event that the random variable X lies within a range of possible values between

$$\left(x - \frac{\Delta x}{2}\right) \text{ and } \left(x + \frac{\Delta x}{2}\right)$$

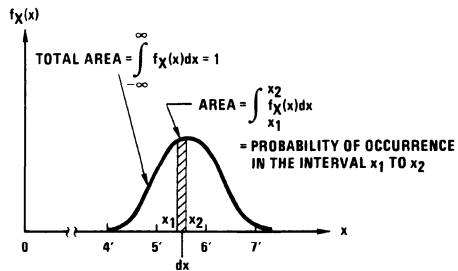
i.e., the area between the two points 5'5" and 5'7" shown in *Figure A.4.2* represents the probability that a man's height will be found in that range. More clearly,

$$(A.4-1)$$

$$\text{Prob} \left[\left(x - \frac{\Delta x}{2}\right) \leq X \leq \left(x + \frac{\Delta x}{2}\right) \right] = \int_{x - \frac{\Delta x}{2}}^{x + \frac{\Delta x}{2}} f_X(x) dx$$

or

$$\text{Prob} [5'5" \leq X \leq 5'7"] = \int_{5'5"}^{5'7"} f_X(x) dx$$



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FIGURE A.4.2

Continuing, since the total of all probabilities of the random variable X must equal unity and $f_X(x) dx$ is the probability that X lies within a specified interval

$$\left(x - \frac{\Delta x}{2}\right) \text{ and } \left(x + \frac{\Delta x}{2}\right),$$

then,

$$\int_{-\infty}^{\infty} f_X(x) dx = 1 \quad (A.4-2)$$

It is important to point out that the density function $f_X(x)$ is in fact a mathematical description of a curve and is not a probability; it is therefore not restricted to values less than unity but can have any non-negative value. Note however, that in practical application, the integral is normalized such that the entire area under the probability density curve equates to unity.

To summarize, a few properties of $f_X(x)$ are listed below.

1. $f_X(x) \geq 0$ for all values of x or $-\infty < x < \infty$

2. $\int_{-\infty}^{\infty} f_X(x) dx = 1$

3. $\text{Prob} \left[\left(x - \frac{\Delta x}{2}\right) \leq X \leq \left(x + \frac{\Delta x}{2}\right) \right]$

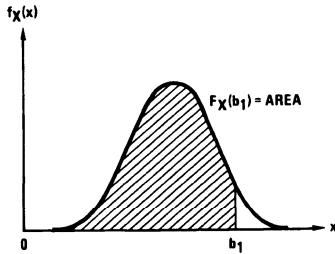
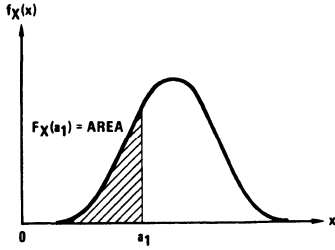
$$= \int_{x - \frac{\Delta x}{2}}^{x + \frac{\Delta x}{2}} f_X(x) dx$$

A.5 CUMULATIVE DISTRIBUTION FUNCTION

If the entire set of probabilities for a random variable event X are known, then since the probability element, $f_X(x) dx$, describes the probability that event X will occur, the accumulation of these probabilities from $x = -\infty$ to $x = \infty$ is unity or an absolutely certain event. Hence,

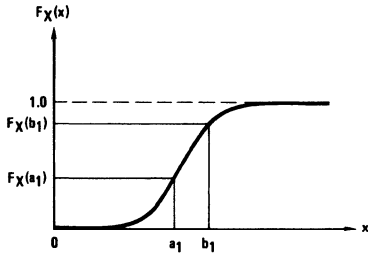
$$F_X(x) \int_{-\infty}^{\infty} f_X(x) dx = 1 \quad (A.5-1)$$

where $F_X(x)$ is defined as the *cumulative distribution function* (cdf) or *distribution function* and $f_X(x)$ is the pdf of random variable X . Illustratively, *Figures A.5.1a* and *A.5.1b* show the probability density function and cumulative distribution function respectively.



(a) Probability Density Function

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(b) Cumulative Distribution Function

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FIGURE A.5.1

In many texts the notation used in describing the cdf is

$$F_X(x) = \text{Prob}[X \leq x] \quad (\text{A.5-2})$$

and is defined to be the probability of the event that the observed random variable X is less than or equal to the allowed or conditional value x . This implies

$$F_X(x) = \text{Prob}[X \leq x] = \int_{-\infty}^x f_X(x) dx \quad (\text{A.5-3})$$

It can be further noted that

$$\text{Prob}[x_1 \leq x \leq x_2] = \int_{x_1}^{x_2} f_X(x) dx = F_X(x_2) - F_X(x_1) \quad (\text{A.5-4})$$

and that from equation (A.5-1) the pdf can be related to the cdf by the derivative

$$f_X(x) = \frac{d[F_X(x)]}{dx} \quad (\text{A.5-5})$$

Re-examining *Figure A.5.1* does indeed show that the pdf, $f_X(x)$, is a plot of the differential change in slope of the cdf, $F_X(x)$.

$F_X(x)$ and a summary of its properties.

1. $0 \leq F_X(x) \leq 1 \quad -\infty < x < \infty$ (Since $F_X = \text{Prob}[X < x]$ is a probability)
2. $F_X(-\infty) = 0 \quad F_X(+\infty) = 1$
3. $F_X(x)$ the probability of occurrence increases as x increases
4. $F_X(x) = \int f_X(x) dx$
5. $\text{Prob}(x_1 \leq x \leq x_2) = F_X(x_2) - F_X(x_1)$

A.6 MEAN VALUES, VARIANCES AND STANDARD DEVIATION

The procedure of determining the average weight of a group of objects by summing their individual weights and dividing by the total number of objects gives the average value of x . Mathematically the discrete *sample mean* can be described

$$\bar{x} = \frac{1}{n} \sum_{i=1}^n x_i \quad (\text{A.6-1})$$

for the continuous case that *mean value* of the random variable X is defined as

$$\bar{x} = E[X] = \int_{-\infty}^{\infty} x f_X(x) dx \quad (\text{A.6-2})$$

where $E[X]$ is read "the expected value of X ".

Other names for the same *mean value* \bar{x} or the *expected value* $E[X]$ are average value and statistical average.

It is seen from equation (A.6-2) that $E[X]$ essentially represents the sum of all possible values of x with each value being weighted by a corresponding value of the probability density function of $f_X(x)$.

Extending this definition to any function of X for example $h(x)$, equation (A.6-2) becomes

$$E[h(x)] = \int_{-\infty}^{\infty} h(x) f_X(x) dx \quad (\text{A.6-3})$$

An example at this point may help to clarify matters. Assume a uniformly dense random variable of density $1/4$ between the values 2 and 6, see *Figure A.6.1*. The use of equation (A.6-2) yields the expected value

$$\bar{x} = E[X] = \int_2^6 x \cdot \frac{1}{4} dx = \frac{x^2}{8} \Big|_2^6 = 4$$

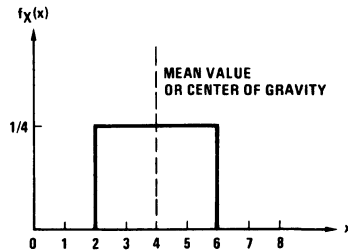


FIGURE A.6.1

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which can also be interpreted as the first moment or center of gravity of the density function $f_X(x)$. The above operation is analogous to the techniques in electrical engineering where the DC component of a time function is found by first integrating and then dividing the resultant area by the interval over which the integration was performed.

Generally speaking, the time averages of random variable functions of time are extremely important since essentially no statistical meaning can be drawn from a single random variable (defined as the value of a time function at a given single instant of time). Thus, the operation of finding the *mean value* by integrating over a specified range of possible values that a random variable may assume is referred to as *ensemble averaging*.

In the above example, \bar{x} was described as the first moment m_1 or DC value. The mean-square value \bar{x}^2 or $E[X^2]$ is the second moment m_2 or the total average power, AC plus DC and in general the n th moment can be written

$$m_n = E[X^n] = \int_{-\infty}^{\infty} [h(x)]^2 f_X(x) dx \quad (\text{A.6-4})$$

Note that the first moment squared m_1^2 , \bar{x}^2 or $E[X]^2$ is equivalent to the DC power through a 1Ω resistor and is *not* the same as the second moment m_2 , \bar{x}^2 or $E[X]^2$ which, again, implies the total average power.

A discussion of central moments is next in store and is simply defined as the moments of the difference (deviation) between a random variable and its mean value. Letting $[h(x)]^n = (X - \bar{x})^n$, mathematically

$$\overline{(X - \bar{x})^n} = E[(X - \bar{x})^n] = \int_{-\infty}^{\infty} (X - \bar{x})^n f_X(x) dx \quad (\text{A.6-5})$$

For $n = 1$, the first central moment equals zero i.e., the AC voltage (current) minus the mean, average or DC voltage (current) equals zero. This essentially yields little information. The second central moment, however, is so important that it has been named the *variance* and is symbolized by σ^2 . Hence,

$$\sigma^2 = E[(X - \bar{x})^2] = \int_{-\infty}^{\infty} (X - \bar{x})^2 f_X(x) dx \quad (\text{A.6-6})$$

Note that because of the squared term, values of X to either side of the mean \bar{x} are equally significant in measuring variations or deviations away from \bar{x} i.e., if $\bar{x} = 10$, $X_1 = 12$ and $X_2 = 8$ then $(12 - 10)^2 = 4$ and $(8 - 10)^2 = 4$ respectively. The variance therefore is the measure of the variability of $[h(x)]^2$ about its mean value \bar{x} or the expected square deviation of X from its mean value. Since,

$$\sigma^2 = E[(X - \bar{x})^2] = E[X^2 - 2\bar{x}X + \bar{x}^2] \quad (\text{A.6-7a})$$

$$= E[X^2] - 2\bar{x}E[X] + \bar{x}^2 \quad (\text{A.6-7b})$$

$$= \bar{x}^2 - 2\bar{x}\bar{x} + \bar{x}^2 \quad (\text{A.6-7c})$$

$$= \bar{x}^2 - \bar{x}_1^2 \quad (\text{A.6-7d})$$

or

$$m_2 - m_1^2 \quad (\text{A.6-7e})$$

The analogy can be made that variance is essentially the average AC power of a function $h(x)$, hence, the total average power, second moment m_2 , minus the DC power, first moment squared m_1^2 . The positive square root of the variance.

$$\sqrt{\sigma^2} = \sigma$$

is defined as the *standard deviation*. The mean indicates where a density is centered but gives no information about how spread out it is. This spread is measured by the standard deviation σ and is a measure of the spread of the density function about \bar{x} , i.e., the smaller σ the closer the values of X to the mean. In relation to electrical engineering the standard deviation is equal to the root-mean-square (rms) value of an AC voltage (current) in circuit.

A summary of the concepts covered in this section are listed in Table A.6.1.

A.7 FUNCTIONS OF TWO JOINTLY DISTRIBUTED RANDOM VARIABLES

The study of jointly distributed random variables can perhaps be clarified by considering the response of linear systems to random inputs. Relating the output of a system to its input is an example of analyzing two random variables from different random processes. If on the other hand an attempt is made to relate present or future values to its past values, this, in effect, is the study of random variables coming from the same process at different instances of time. In either case, specifying the relationship between the two random variables is established by initially developing a probability model for the joint occurrence of two random events. The following sections will be concerned with the development of these models.

A.8 JOINT CUMULATIVE DISTRIBUTION FUNCTION

The joint cumulative distribution function (cdf) is similar to the cdf of Section A.5 except now two random variables are considered.

$$F_{XY}(x,y) = \text{Prob}[X \leq x, Y \leq y] \quad (\text{A.8-1})$$

defines the joint cdf, $F_{XY}(x,y)$, of random variables X and Y . Equation (A.8-1) states that $F_{XY}(x,y)$ is the probability associated with the joint occurrence of the event that X is less than or equal to an allowed or conditional value x and the event that Y is less than or equal to an allowed or conditional value y .

TABLE A.6-1

Symbol	Name	Physical Interpretation
$\bar{X}, E[X], m_1: \int_{-\infty}^{\infty} x f_X(x) dx$	Expected Value, Mean Value, Statistical Average Value	<ul style="list-style-type: none"> Finding the mean value of a random voltage (current) is equivalent to finding its DC component. First moment; e.g., the first moment of a group of masses is just the average location of the masses or their center of gravity. The range of the most probable values of x.
$E[X]^2, \bar{X}^2, m_1^2$		<ul style="list-style-type: none"> DC power
$\bar{X}^2, E[X^2], m_2: \int_{-\infty}^{\infty} x^2 f_X(x) dx$	Mean Square Value	<ul style="list-style-type: none"> Interpreted as being equal to the time average of the square of a random voltage (current). In such cases the mean-square value is proportional to the total average power (AC plus DC) through a 1Ω resistor and its square root is equal to the rms or effective value of the random voltage (current). Second moment; e.g., the moment of inertia of a mass or the turning moment of torque about the origin. The mean-square value represents the spread of the curve about $\bar{x} = 0$
$\text{var}[], \sigma^2, (X - \bar{X})^2, E[(X - \bar{X})^2],$ $m_2: \int_{-\infty}^{\infty} (X - \bar{X})^2 f_X(x) dx$	Variance	<ul style="list-style-type: none"> Related to the average power (in a 1Ω resistor) of the AC components of a voltage (current) in power units. The square root of the variances is the rms voltage (current) again not reflecting the DC component. Second moment; for example the moment of inertia of a mass or the turning moment of torque about the value \bar{x}. Represents the spread of the curve about the value \bar{x}.
$\sqrt{\sigma^2}, \sigma$	Standard Deviation	<ul style="list-style-type: none"> Effective rms AC voltage (current) in a circuit. A measure of the spread of a distribution corresponding to the amount of uncertainty or error in a physical measurement or experiment. Standard measure of deviation of X from its mean value \bar{x}.

$(\bar{x})^2$ is a result of smoothing the data and then squaring it and (\bar{x}^2) results from squaring the data and then smoothing it.

A few properties of the joint cumulative distribution function are listed below.

$$1. 0 \leq F_{XY}(x,y) \leq 1 \quad \begin{array}{l} -\infty < x < \infty \\ -\infty < y < \infty \end{array}$$

(since $F_{XY}(x,y) = \text{Prob}[X \leq x, Y \leq y]$ is a probability)

$$2. F_{XY}(-\infty, y) = 0$$

$$F_{XY}(x, -\infty) = 0$$

$$F_{XY}(-\infty, -\infty) = 0$$

$$3. F_{XY}(+\infty, +\infty) = 0$$

$$4. F_{XY}(x,y) \quad \text{The probability of occurrence increases as either } x \text{ or } y, \text{ or both increase}$$

A.9 JOINT PROBABILITY DENSITY FUNCTION

Similar to the single random variable probability density function (pdf) of sections A.4 and A.5, the joint probability density function $f_{XY}(x, y)$ is defined as the partial derivative of the joint cumulative distribution function $F_{XY}(x, y)$. More clearly,

$$f_{XY}(x,y) = \frac{d^2}{dx dy} F_{XY}(x,y) \quad (\text{A.9-1})$$

Recall that the pdf is a *density* function and must be integrated to find a probability. As an example, to find the probability that (X, Y) is within a rectangle of dimension $(x_1 \leq X \leq x_2)$ and $(y_1 \leq Y \leq y_2)$, the pdf of the joint or two-dimensional random variable must be integrated over both ranges as follows,

$$\text{Prob}[x_1 \leq X \leq x_2, y_1 \leq Y \leq y_2] = \quad (\text{A.9-2})$$

$$\int_{x_1}^{x_2} \int_{y_1}^{y_2} f_{XY}(x,y) dy dx = 1$$

It is noted that the double integral of the joint pdf is in fact the cumulative distribution function

$$F_{XY}(x, y) = \int \int_{-\infty}^{\infty} f_{XY}(x, y) dx dy = 1 \quad (\text{A.9-3})$$

analogous to Section A.5. Again $f_{XY}(x, y) dx dy$ represents the probability that X and Y will jointly be found in the ranges

$$x \pm \frac{dx}{2} \text{ and } y \pm \frac{dy}{2},$$

respectively, where the joint density function $f_{XY}(x, y)$ has been normalized so that the volume under the curve is unity.

A few properties of the joint probability density functions are listed below.

$$1. f_{XY}(x,y) > 0 \quad \text{For all values of } x \text{ and } y \text{ or } -\infty < x < \infty \text{ and } -\infty < y < \infty, \text{ respectively}$$

$$2. \int \int_{-\infty}^{\infty} f_{XY}(x,y) dx dy = 1$$

$$3. F_{XY}(x,y) = \int_{-\infty}^y \int_{-\infty}^x f_{XY}(x,y) dx dy$$

$$4. \text{Prob}[x_1 \leq X \leq x_2, y_1 \leq Y \leq y_2] = \int_{y_1}^{y_2} \int_{x_1}^{x_2} f_{XY}(x,y) dx dy$$

A.10 STATISTICAL INDEPENDENCE

If the knowledge of one variable gives no information about the value of the other, the two random variables are said to be statistically independent. In terms of the joint pdf

$$f_{XY}(x,y) = f_X(x) f_Y(y) \quad (\text{A.10-1})$$

and

$$f_X(x) f_Y(y) = f_{XY}(x,y) \quad (\text{A.10-2})$$

imply statistical independence of the random variables X and Y . In the same respect the joint cdf

$$F_{XY}(x, y) = F_X(x)F_Y(y) \quad (\text{A.10-3})$$

and

$$F_X(x)F_Y(y) = F_{XY}(x, y) \quad (\text{A.10-4})$$

again implies this independence.

It is important to note that for the case of the expected value $E[XY]$, statistical independence of random variables X and Y implies

$$E[XY] = E[X] E[Y] \quad (\text{A.10-5})$$

but, the converse is *not* true since random variables can be uncorrelated but not necessarily independent.

In summary

1. $F_{XY}(x,y) = F_X(x) F_Y(y)$ reversible
2. $f_{XY}(x,y) = f_X(x) f_Y(y)$ reversible
3. $E[XY] = E[X] E[Y]$ non-reversible

A.11 MARGINAL DISTRIBUTION AND MARGINAL DENSITY FUNCTIONS

When dealing with two or more random variables that are jointly distributed, the distribution of each random variable is called the *marginal distribution*. It can be shown that the marginal distribution defined in terms of a joint distribution can be manipulated to yield the distribution of each random variable considered by itself. Hence, the marginal distribution functions $F_X(x)$ and $F_Y(y)$ in terms of $F_{XY}(x, y)$ are

$$F_X(x) = F_{XY}(x, \infty) \quad (\text{A.11-1})$$

and

$$F_Y(y) = F_{XY}(\infty, y) \quad (\text{A.11-2})$$

respectively.

The marginal density functions $f_X(x)$ and $f_Y(y)$ in relation to the joint density $f_{XY}(x, y)$ is represented as

$$f_X(x) = \int_{-\infty}^{\infty} f_{XY}(x, y) dy \quad (\text{A.11-3})$$

and

$$f_Y(y) = \int_{-\infty}^{\infty} f_{XY}(x, y) dx \quad (\text{A.11-4})$$

respectively.

A.12 TERMINOLOGY

Before continuing into the following sections it is appropriate to provide a few definitions of the terminology used hereafter. Admittedly, the definitions presented are by no means complete but are adequate and essential to the continuity of the discussion.

Deterministic and Nondeterministic Random Processes: A random process for which its future values cannot be exactly predicted from the observed past values is said to be *nondeterministic*. A random process for which the future values of any sample function can be exactly predicted from a knowledge of all past values, however, is said to be a *deterministic* process.

Stationary and Nonstationary Random Processes: If the marginal and joint density functions of an event do not depend upon the choice of i.e., time origin, the process is said to be *stationary*. This implies that the mean values and moments of the process are constants and are not dependent upon the absolute value of time. If on the other hand the probability density functions do change with the choice of time origin, the process is defined *nonstationary*. For this case one or more of the mean values or moments are also time dependent. In the strictest sense, the stochastic process $x(t)$ is stationary if its statistics are not affected by the shift in time origin i.e., the process $x(t)$ and $x(t + \tau)$ have the same statistics for any τ .

Ergodic and Nonergodic Random Processes: If every member of the ensemble in a stationary random process exhibits the same statistical behavior that the entire ensemble has, it is possible to determine the process statistical behavior by examining only one typical sample function. This is defined as an *ergodic* process and its mean value and moments can be determined by time averages as well as by ensemble averages. Further ergodicity implies a stationary process and any process not possessing this property is *nonergodic*.

Mathematically speaking, any random process or, i.e., wave shape $x(t)$ for which

$$\lim_{T \rightarrow \infty} \overline{x(t)} = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} x(t) dt = E[x(t)]$$

holds true is said to be an ergodic process. This simply says that as the averaging time, T , is increased to the limit $T \rightarrow \infty$, time averages equal ensemble averages (the *expected value* of the function).

A.13 JOINT MOMENTS

In this section, the concept of joint statistics of two continuous dependent variables and a particular measure of this dependency will be discussed.

The joint moments m_{ij} of the two random variables X and Y are defined as

$$m_{ij} = E[X^i Y^j] = \int_{-\infty}^{\infty} \int_{-\infty}^{\infty} x^i y^j f_{XY}(x, y) dx dy \quad (\text{A.13-1})$$

where $i + j$ is the order of the moment.

The second moment represented as μ_{11} or σ_{XY} serves as a measure of the dependence of two random variables and is given a special name called the *covariance* of X and Y . Thus

$$\mu_{11} = \sigma_{XY} = E[(X - \bar{x})(Y - \bar{y})] = \int_{-\infty}^{\infty} \int_{-\infty}^{\infty} (X - \bar{x})(Y - \bar{y}) f_{XY}(x, y) dx dy \quad (\text{A.13-2})$$

$$= E[XY] - E[X] E[Y] \quad (\text{A.13-3})$$

or

$$= m_{11} - \bar{x}\bar{y} \quad (\text{A.13-4})$$

If the two random variables are independent, their covariance function μ_{11} is equal to zero and m_{11} , the average of the product, becomes the product of the individual averages hence.

$$\mu_{11} = 0 \quad (\text{A.13-5})$$

implies

$$m_{11} = E[(X - \bar{x})(Y - \bar{y})] = E[X - \bar{x}] E[Y - \bar{y}] \quad (\text{A.13-6})$$

Note, however, the converse of this statement in general is not true but does have validity for two random variables possessing a joint (two dimensional) Gaussian distribution.

In some texts the name cross-covariance is used instead of covariance, regardless of the name used they both describe processes of two random variables each of which comes from a separate random source. If, however, the two random variables come from the same source it is instead called the *autovariance* or *auto-covariance*.

It is now appropriate to define a normalized quantity called the *correlation coefficient*, ρ , which serves as a numerical measure of the dependence between two random variables. This coefficient is the covariance normalized, namely

$$\rho = \frac{\text{covar}[X, Y]}{\sqrt{\text{var}[X]} \sqrt{\text{var}[Y]}} = \frac{E\{[X - E[X]][Y - E[Y]]\}}{\sqrt{\sigma_X^2} \sqrt{\sigma_Y^2}} \quad (\text{A.13-7})$$

$$= \frac{\mu_{11}}{\sigma_X \sigma_Y} \quad (\text{A.13-8})$$

where ρ is a dimensionless quantity

$$-1 \leq \rho \leq 1$$

Values close to 1 show high correlation of i.e., two random waveforms and those close to -1 show high correlation of the same waveform except with opposite sign. Values near zero indicate low correlation.

A.14 CORRELATION FUNCTIONS

If $x(t)$ is a sample function from a random process and the random variables

$$x_1 = x(t_1)$$

$$x_2 = x(t_2)$$

are from this process, then, the *autocorrelation* function $R(t_1, t_2)$ is the joint moment of the two random variables;

$$R_{xx}(t_1, t_2) = E[x(t_1)x(t_2)] \quad (\text{A.14-1})$$

$$= \int \int_{-\infty}^{\infty} x_1 x_2 f_{x_1 x_2}(x_1, x_2) dx_1 dx_2$$

where the autocorrelation is a function of t_1 and t_2 .

The auto-covariance of the process $x(t)$ is the covariance of the random variables $x(t_1)$ $x(t_2)$

$$c_{xx}(t_1, t_2) = E\{[x(t_1) - \bar{x}(t_1)][x(t_2) - \bar{x}(t_2)]\} \quad (\text{A.14-2})$$

or rearranging equation (A.14-1)

$$\begin{aligned} c(t_1, t_2) &= E\{[x(t_1) - \bar{x}(t_1)][x(t_2) - \bar{x}(t_2)]\} \\ &= E\{x(t_1)x(t_2) - x(t_1)\bar{x}(t_2) - \bar{x}(t_1)x(t_2) \\ &\quad + \bar{x}(t_1)\bar{x}(t_2)\} \\ &= E\{x(t_1)x(t_2) - x(t_1)E[x(t_2)] - E[x(t_1)]x(t_2) \\ &\quad + E[x(t_1)]E[x(t_2)]\} \\ &= E[x(t_1)x(t_2)] - E[x(t_1)]E[x(t_2)] \\ &\quad - E[x(t_1)]E[x(t_2)] + E[x(t_1)]E[x(t_2)] \\ &= E[x(t_1)x(t_2)] - E[x(t_1)]E[x(t_2)] \end{aligned} \quad (\text{A.14-3})$$

or

$$= R(t_1, t_2) - E[x(t_1)]E[x(t_2)] \quad (\text{A.14-4})$$

The autocorrelation function as defined in equation (A.14-1) is valid for both stationary and nonstationary processes. If $x(t)$ is stationary then all its ensemble averages are independent of the time origin and accordingly

$$R_{xx}(t_1, t_2) = R_{xx}(t_1 + T, t_2 + T) \quad (\text{A.14-5a})$$

$$= E[x(t_1 + T)x(t_2 + T)] \quad (\text{A.14-5b})$$

Due to this time origin independence, T can be set equal to $-t_1$, $T = -t_1$, and substitution into equations (A.14-5a, b)

$$R_{xx}(t_1, t_2) = R_{xx}(0, t_2 - t_1) \quad (\text{A.14-6a})$$

$$= E[x(0)x(t_2 - t_1)] \quad (\text{A.14-6b})$$

imply that the expression is only dependent upon the time difference $t_2 - t_1$. Replacing the difference with $\tau = t_2 - t_1$ and suppressing the zero in the argument $R_{xx}(0, t_2 - t_1)$ yields

$$R_{xx}(\tau) = E[x(t_1)x(t_1 - \tau)] \quad (\text{A.14-7})$$

Again since this is a stationary process it depends only on τ . The lack of dependence on the particular time, t_1 , at which the ensemble was taken allows equation (A.14-7) to be written without the subscript, i.e.,

$$R_{xx}(\tau) = E[x(t)x(t + \tau)] \quad (\text{A.14-8})$$

as it is found in many texts. This is the expression for the autocorrelation function of a stationary random process.

For the autocorrelation function of a nonstationary process where there is a dependence upon the particular time at which the ensemble average was taken as well as on the time difference between samples, the expression must be written with identifying subscripts, i.e., $R_{xx}(t_1, t_2)$ or $R_{xx}(t_1, \tau)$.

The time autocorrelation function can be defined next and has the form

$$R_{xx}(\tau) = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} x(t)x(t + \tau) dt \quad (\text{A.14-9})$$

For the special case of an ergodic process (Ref. Appendix A.12) the two functions, equations (A.14-8) and (A.14-9), are equal

$$R_{xx}(\tau) = R_{xx}(\tau) \quad (\text{A.14-10})$$

It is important to point out that if $\tau = 0$ in equation (A.14-7) the autocorrelation function

$$R_{xx}(0) = E[x(t_1)x(t_1)] \quad (\text{A.14-11})$$

would equal the mean square value or total power (AC plus DC) of the process. Further, for values other than $\tau = 0$, $R_x(\tau)$ represents a measure of the similarity between its waveforms $x(t)$ and $x(t + \tau)$.

In the same respect as the previous discussion, two random variables from two different jointly stationary random processes $x(t)$ and $y(t)$ have for the random variables

$$\begin{aligned} x_1 &= x(t_1) \\ y_2 &= y(t_1 + \tau) \end{aligned}$$

the *crosscorrelation* function

$$\begin{aligned} R_{xy}(\tau) &= E\{x(t_1)y(t_1 + \tau)\} \\ &= \int \int_{-\infty}^{\infty} x_1 y_2 f_{x_1 y_2}(x_1, y_2) dx_1 dy_2 \end{aligned} \tag{A.14-12}$$

The crosscorrelation function is simply a measure of how much these two variables depend upon one another.

Since it was assumed that both random processes were jointly stationary, the crosscorrelation is thus only dependent upon the time difference τ and, therefore

$$R_{xy}(\tau) = R_{yx}(\tau) \tag{A.14-13}$$

where

$$\begin{aligned} y_1 &= y(t_1) \\ x_2 &= x(t_1 + \tau) \end{aligned}$$

and

$$\begin{aligned} R_{yx}(\tau) &= E\{y(t_1)x(t_1 + \tau)\} \\ &= \int \int_{-\infty}^{\infty} y_1 x_2 f_{y_1 x_2}(y_1, x_2) dy_1 dx_2 \end{aligned} \tag{A.14-14}$$

The time crosscorrelation functions are defined as before by

$$R_{xy}(\tau) = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} x(t)y(t + \tau) dt \tag{A.14-15}$$

and

$$R_{yx}(\tau) = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{T/2} y(t)x(t + \tau) dt \tag{A.14-16}$$

and finally

$$R_{xy}(\tau) = R_{xy}(\tau) \tag{A.14-17}$$

$$R_{yx}(\tau) = R_{yx}(\tau) \tag{A.14-18}$$

for the case of jointly ergodic random processes.

APPENDIX B

B.0 INTERCHANGING TIME INTEGRATION AND EXPECTATIONS

If $f(t)$ is a nonrandom time function and $a(t)$ a sample function from a random process then,

$$E \left[\int_{t_1}^{t_2} a(t) f(t) dt \right] = \int_{t_1}^{t_2} E[a(t)] f(t) dt \tag{B.0-1}$$

This is true under the condition

$$a) \int_{t_1}^{t_2} E[|a(t)|] |f(t)| dt < \infty \tag{B.0-2}$$

b) $a(t)$ is bounded by the interval t_1 to t_2 . [t_1 and t_2 may be infinite and $a(t)$ may be either stationary or nonstationary]

APPENDIX C

C.0 CONVOLUTION

This appendix defines convolution and presents a short proof without elaborate explanation. For complete definition of convolution refer to National Semiconductor Application Note AN-237.

For the *time convolution* if

$$f(t) \longleftrightarrow F(\omega) \tag{C.0-1}$$

$$x(t) \longleftrightarrow X(\omega) \tag{C.0-2}$$

then

$$\tag{C.0-3}$$

$$y(t) = \int_{-\infty}^{\infty} x(\tau) f(t - \tau) d\tau \longleftrightarrow Y(\omega) = X(\omega) * F(\omega)$$

or

$$y(t) = x(t) * f(t) \longleftrightarrow Y(\omega) = X(\omega) * F(\omega) \tag{C.0-4}$$

proof:

Taking the Fourier transform, $F[\]$, of $y(t)$

$$F[y(t)] = Y(\omega) = \int_{-\infty}^{\infty} \left[\int_{-\infty}^{\infty} x(\tau) f(t - \tau) d\tau \right] e^{-j\omega t} dt \tag{C.0-5}$$

$$Y(\omega) = \int_{-\infty}^{\infty} x(\tau) \left[\int_{-\infty}^{\infty} f(t - \tau) e^{-j\omega t} dt \right] d\tau \tag{C.0-6}$$

and letting $k = t - \tau$, then, $dk = dt$ and $t = k + \tau$.

Thus,

$$Y(\omega) = \int_{-\infty}^{\infty} x(\tau) \left[\int_{-\infty}^{\infty} f(k) \epsilon^{-j\omega(k + \tau)} dk \right] d\tau \quad (\text{C.0-7})$$

$$= \int_{-\infty}^{\infty} x(\tau) \epsilon^{-j\omega\tau} d\tau \int_{-\infty}^{\infty} f(k) \epsilon^{-j\omega k} dk \quad (\text{C.0-8})$$

$$Y(\omega) = X(\omega) \bullet F(\omega) \quad (\text{C.0-9})$$

For the *frequency convolution* of

$$f(t) \longleftrightarrow F(\omega) \quad (\text{C.0-10})$$

$$x(t) \longleftrightarrow X(\omega) \quad (\text{C.0-11})$$

then

$$H(\omega) = \frac{1}{2\pi} \int_{-\infty}^{\infty} F(\nu) X(\omega - \nu) d\nu \longleftrightarrow h(t) = f(t) \bullet x(t) \quad (\text{C.0-12})$$

or

$$H(\omega) = \frac{1}{2\pi} F(\omega) \bullet X(\omega) \longleftrightarrow h(t) = f(t) \bullet x(t) \quad (\text{C.0-13})$$

proof:

Taking the inverse Fourier transform $F^{-1}[\]$ of equation (C.0-13)

$$h(t) = F^{-1} \left[\frac{x(\omega) \bullet F(\omega)}{2\pi} \right] \quad (\text{C.0-14})$$

$$= \frac{1}{2\pi} \int_{-\infty}^{\infty} \left[\frac{1}{2\pi} \int_{-\infty}^{\infty} F(\nu)(\omega - \nu) d\nu \right] \epsilon^{j\omega t} d\omega$$

$$= \left(\frac{1}{2\pi} \right)^2 \int_{-\infty}^{\infty} F(\nu) \int_{-\infty}^{\infty} X(\omega - \nu) \epsilon^{j\omega t} d\omega d\nu \quad (\text{C.0-15})$$

and letting $g = \omega - \nu$, then $dg = d\omega$ and $\omega = g + \nu$.

Thus,

$$F^{-1} \frac{X(\omega) \bullet F(\omega)}{2\pi} \quad (\text{C.0-16})$$

$$h(t) = \left(\frac{1}{2\pi} \right)^2 \int_{-\infty}^{\infty} F(\nu) \int_{-\infty}^{\infty} X(g) \epsilon^{j(g + \nu)t} dg d\nu$$

$$h(t) = \frac{1}{2\pi} \int_{-\infty}^{\infty} F(\nu) \epsilon^{j\nu t} d\nu \bullet \int_{-\infty}^{\infty} X(g) \epsilon^{jg t} dg \quad (\text{C.0-17})$$

$$h(t) = f(t) \bullet x(t) \quad (\text{C.0-18})$$

APPENDIX D

D.0 REFERENCES

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Circuitry for Inexpensive Relative Humidity Measurement

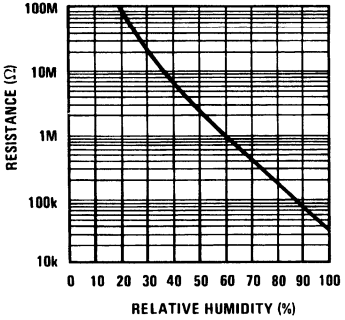
National Semiconductor
Application Note 256



Of all common environmental parameters, humidity is perhaps the least understood and most difficult to measure. The most common electronic humidity detection methods, albeit highly accurate, are not obvious and tend to be expensive and complex (See Box). Accurate humidity measurement is vital to a number of diverse areas, including food processing, paper and lumber production, pollution monitoring and chemical manufacturing. Despite these and other applications, little design oriented material has appeared on circuitry to measure humidity. This is primarily due to the small number of transducers available and a generally accepted notion that they are difficult and expensive to signal condition.

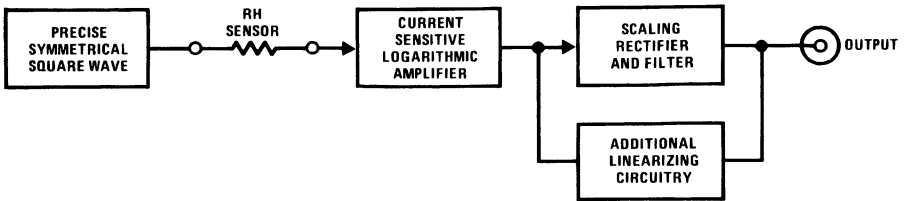
Although not as accurate as other methods, the sensor described by the response curve (Figure 1) is inexpensive and provides a direct readout of relative humidity. The curve

reveals a close exponential relationship between the sensor and relative humidity spanning almost 4 decades of resistance. Linearization of this curve may be accomplished by taking the logarithm of the resistance value and utilizing breakpoint approximation techniques to minimize the residual non-linearities. A further consideration in signal conditioning is that the manufacturer specifies that no significant DC current component may pass through the sensor. This device must be excited with an unbiased AC waveform to preclude detrimental electrochemical migration. In addition, it has a 0.36 RH unit/°C positive temperature coefficient. The sensor is a chemically treated styrene copolymer which has a surface layer whose resistivity varies with relative humidity. Because the humidity sensitive portion of the sensor is at its surface, time response is reasonably rapid and is on the order of seconds.



TL/H/8713-1

FIGURE 1. Phys-Chemical Research Corp. Model PCRC-55 Humidity Sensor



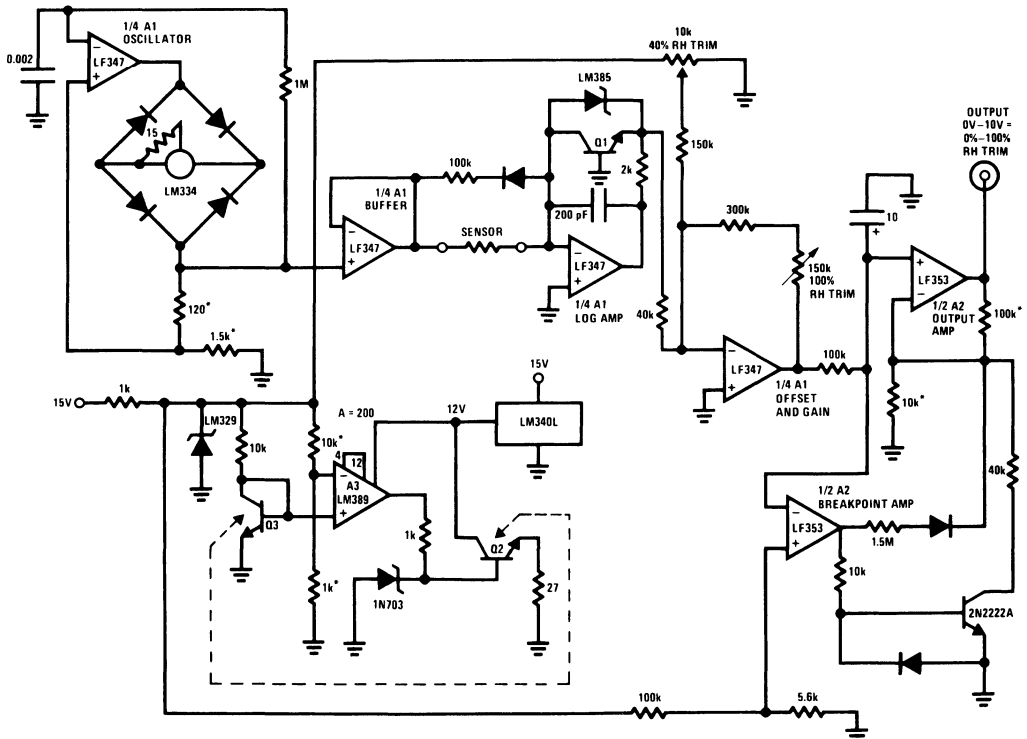
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FIGURE 2

The detailed circuitry appears in *Figure 3*. It is worth noting that the entire function described in *Figure 2* requires a small number of inexpensive ICs. This is accomplished by novel circuitry approaches, especially in the design of the logarithmic amplifier. The stabilized symmetrical square wave is generated by A1, $\frac{1}{4}$ of an LF347 quad amplifier. A1 is set up in a positive feedback configuration, causing it to oscillate. The output of A1 is current limited and clamped to ground for either polarity output by the LM334 current source diode bridge combination. The LM334 is programmed by the 15Ω resistor to current limit at about 5 mA. This forces the voltage across the 120Ω – $1.5\text{ k}\Omega$ resistor string to stabilize at about $\pm 8\text{V}$. Each time A1's output changes state the charging current into the $0.002\ \mu\text{F}$ capacitor reverses, causing the amplifier to switch again when the capacitor reaches a threshold established by the 120Ω – $1.5\text{ k}\Omega$ divider (waveforms, *Figure 4*). This circuit's output is buffered by the A1 follower. The amplitude stability of the waveform is dependent upon the $+0.33\%/^{\circ}\text{C}$ temperature coefficient of the LM334. This T.C. has been intentionally designed into the LM334 so that it may be used in temperature sensing and compensation applications. Here, the negative $0.3\%/^{\circ}\text{C}$

temperature dependence of the humidity sensor is reduced by more than an order of magnitude by the LM334's T.C. and thermally induced inaccuracy in the humidity sensor's response drops out as an error term. In practice, the LM334 should be mounted in proximity to the humidity sensor. The residual $-0.03\%/^{\circ}\text{C}$ temperature coefficient is negligibly small compared to the sensors $\pm 1\%$ accuracy specification.

The output square wave is used to drive current through the sensor and into the summing junction of another $\frac{1}{4}$ of A1, which is connected as a logarithmic amplifier. On negative cycles of the input waveform the transistor (Q1) in the feedback loop provides logarithmic response, due to the well known relationship between V_{BE} and collector current in transistors. During positive excursions of the input waveform the diode provides feedback to the amplifier's summing junction. In this manner the summing junction always remains at virtual ground while the input current is expressed in logarithmic form by the negative going square wave at the transistor emitter. Since the summing junction is always at ground potential the sensor sees the required symmetrical drive (waveforms, *Figure 5*).



LF347 and LF353 run on $\pm 15\text{V}$ supply.

Q1, Q2, Q3 are on LM389 chip.

* = 1% Metal Film

▶ = 1N4148

Sensor = PCRC-55 - Phys-Chemical Research Corporation

A1 = LF347

A2 = LF353

FIGURE 3

TL/H/8713-3

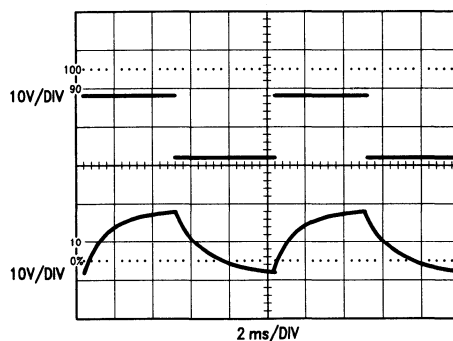
The output of this stage is fed to another $\frac{1}{4}$ of A1. This amplifier is used to sum in the 40% RH trim and provide adjustable gain to set the 100% RH trim. The output is filtered to DC and routed to one half of A2, an LF353, which unloads the filter and provides additional gain and the final output.

The other $\frac{1}{2}$ of A2 is used to compensate the sensor departure from logarithmic conformity below 40% RH (Figure 1). This is accomplished by changing the gain of the output amplifier for RH readings below 40%. The input to the output amplifier is sensed by the breakpoint amplifier. When this input goes below RH = 40% (about 0.36V at the output amplifiers "+" terminal) the breakpoint amplifier swings positive. This turns on the 2N2222A, causing the required gain change to occur at the output amplifier. For RH values above 40% the transistor is off and the circuit's linearizing function is determined solely by the logarithmic amplifier.

In logarithmic configurations such as this, Q1's DC operating point will vary wildly with temperature and the circuit normally requires careful attention to temperature compensation, resulting in the expense associated with logarithmic amplifiers. Here, A3, an LM389 audio amplifier IC which also contains three discrete transistors, is used in an unorthodox configuration to eliminate all temperature compensation requirements. In addition, the cost of the log function is reduced by an order of magnitude compared to available ICs and modules. Q3 functions as a chip temperature sensor while Q2 serves as a heater. The amplifier senses the temperature dependent V_{BE} of Q3 and drives Q2 to servo the chip temperature to the set-point established by the 10 k Ω -1 k Ω divider string. The LM329 reference ensures power supply independence of the temperature control. Q1 operates in this tightly controlled thermal environment (typically 50°C) and is immune to ambient temperature shifts. The LM340L 12V regulator ensures safe operation of the LM389, a 12V device. The zener at the base of Q2 prevents servo lock-up during circuit start-up. Because of the small size of the chip, warm-up is quick and power consumption low. Figure 6 shows the thermal servo's performance for a step function of 7°C change in set-point. The step is shown in trace A while the LM389 output appears in trace B. The output responds almost instantaneously and complete settling to the new set-point occurs within 100 ms.

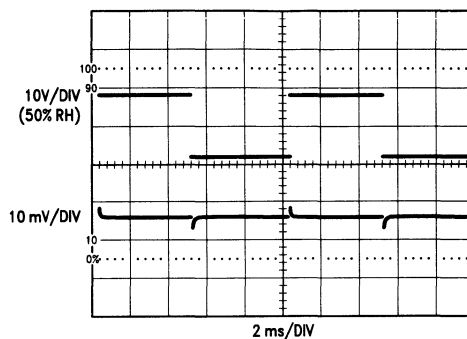
To adjust this circuit, ground the base of Q2, apply circuit power and measure the collector potential of Q3, at known room temperature. Next, calculate what Q3's collector potential will be at 50°C, allowing -2.2 mV/°C. Select the 1k value to yield a voltage close to the calculated 50°C potential at the LM389's negative input. This can be a fairly loose trim, as the exact chip temperature is unimportant so long as it is stable. Finally, unground Q2's base and the circuit will servo. This may be functionally checked by reading Q3's collector voltage and noting stability within 100 μ V (0.05°C) while blowing on A3.

To calibrate the circuit for RH, place a 35 k Ω resistor in the sensor position and trim the 150 k Ω pot for an output of 10V. Next, substitute an 8 M Ω resistor for the sensor and trim the 10k potentiometer for an output of 4V. Repeat this procedure until the adjustments do not interfere with each other. Finally, substitute a 60 M Ω resistor for the sensor and select the nominal 40 k Ω value in the breakpoint amplifier for a reading of RH = 24%. It may be necessary to select the 1.5 M Ω value to minimize "hop" at the circuit output when the breakpoint is activated. The circuit is now calibrated and will read ambient relative humidity when the PCRC-55 sensor is connected.



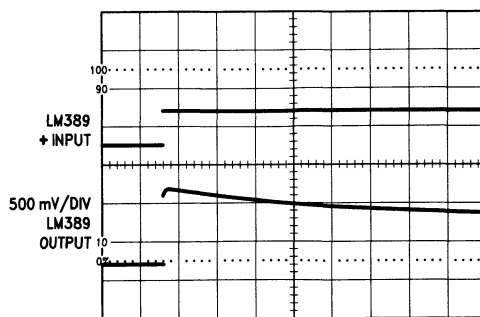
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FIGURE 4



TL/H/8713-5

FIGURE 5



TL/H/8713-6

FIGURE 6

HUMIDITY

Humidity is simply water gas. In air the humidity may vary from zero percent for 90°F dry air to as much as 4.5 percent for heavily water laden air at 90°F. The amount of water air will hold is dependent upon temperature. *Relative* humidity is an expression denoting the ratio of water vapor in the air to the amount possible in saturated air at the same temperature.

Some of the more common ways of expressing humidity related information include wet bulb temperature, dew point and frost point. Wet bulb temperature refers to the minimum temperature reached by a wetted thermometer bulb in a stream of air. The dew point is the point at which water saturation occurs in air. It is evidenced by water condensation. When temperatures below 0°C are required to produce this phenomenon it is called the frost point.

Other measurements and ways of expressing humidity exist and are useful in a variety of applications. For additional information consult the bibliography.

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Data Acquisition Using the ADC0816 and ADC0817 8-Bit A/D Converter with On-Chip 16 Channel Multiplexer

National Semiconductor
Application Note 258
Larry Wakeman



I. Introduction

The ADC0816 and ADC0817, CMOS 16-Channel Data Acquisition devices are selectable multi-input 8-bit A/D converters. In addition to a standard 8-bit successive approximation type A/D converter, these devices contain a 16 channel analog multiplexer with 4-bit latched address inputs. They include much of the circuitry required to build an 8-bit accurate, medium through-put data acquisition system.

These two converters are similar to the ADC0808/ADC0809 A/D converters except that the ADC0816/ADC0817 have 16 analog inputs instead of 8, and the multiplexer output and the A/D comparator input are externally available. (The ADC0808/ADC0809 connect these internally.) This feature is useful when connecting signal processing circuitry to the A/D. Also the ADC0816/ADC0817 have an expansion control pin to allow addition of more multiplexers, hence more input channels.

The ADC0816 is identical to the ADC0817 except for accuracy. The ADC0816 is the more accurate part, having a total unadjusted error of $\pm 1/2$ LSB. The ADC0817 has a total unadjusted error ± 1 LSB. In many applications where a slightly lower accuracy is tolerable, the ADC0817 represents a more economical solution.

II. Functional Description

The ADC0816/ADC0817 can be subdivided into two major functional blocks; a multiplexer/latch and an A/D converter, *Figure 1*. The multiplexer/latch is composed of a 16 channel multiplexer, a 4 bit channel select register, and some channel select decoding circuitry.

The channel select address is loaded on the positive transition of the Address Latch Enable (ALE) input. *Figure 2*

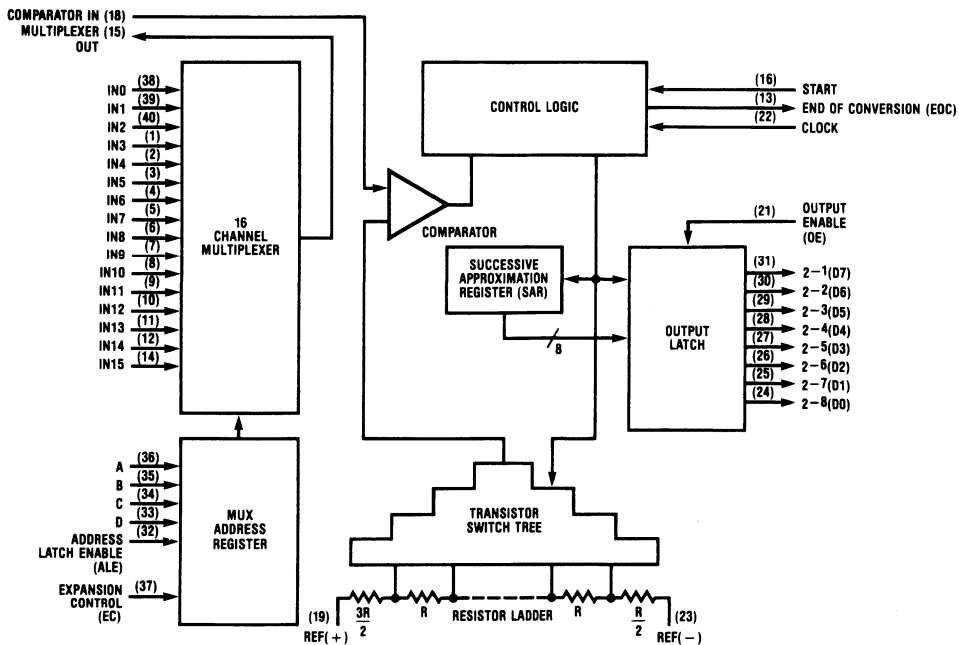


FIGURE 1. ADC0816/ADC0817 Functional Block Diagram

TL/H/5624-1

shows this addressing scheme. A multiplexer enable pin called Expansion Control (EC) is also provided. Taking this pin low will disable the on chip multiplexer, allowing other multiplexers to be used, thus expanding the number of inputs.

Address				Expansion Control	Selected Channel
D	C	B	A		
0	0	0	0	1	IN0
0	0	0	1	1	IN1
0	0	1	0	1	IN2
0	0	1	1	1	IN3
0	1	0	0	1	IN4
0	1	0	1	1	IN5
0	1	1	0	1	IN6
0	1	1	1	1	IN7
1	0	0	0	1	IN8
1	0	0	1	1	IN9
1	0	1	0	1	IN10
1	0	1	1	1	IN11
1	1	0	0	1	IN12
1	1	0	1	1	IN13
1	1	1	0	1	IN14
1	1	1	1	1	IN15
X	X	X	X	0	NONE

FIGURE 2. Analog Input Selection Table

The output of the multiplexer usually feeds the input of the second major functional block, the A/D converter. This converter is a successive approximation type converter that is composed of a comparator, 256R type resistor ladder, successive approximation register (SAR), control logic, and output data latch.

Under normal operation the control logic of the A/D will first detect a positive going pulse on the START input. On the rising edge of this pulse the internal registers are cleared, and will remain clear as long as START is high. When the START input goes low, the conversion is initiated. The control logic will cycle to the beginning of the next approximation cycle at which time End of Conversion goes low and the conversion is started. During a conversion, the control logic will select a tap on the resistor ladder, and route the signal through a transistor switch tree to the input of the comparator. The comparator will decide whether this tap voltage is higher or lower than the input signal and indicate this to the control logic. The control logic then decides which tap is to be selected next. Meanwhile, the SAR maintains a record of the conversion's progress. This algorithm takes 8 clock periods per approximation and requires 8 approximations to convert 8 bits. Thus 64 clock periods are required for a complete conversion.

Once the entire conversion is completed the data in the SAR is loaded into the output register. This is a TRI-STATE® register which requires that its outputs be enabled by rising the Output Enable (OE or TRI-STATE) input. The data can then be read by the controlling logic.

During operation, the EOC output must be monitored to determine whether the device is actively converting or is ready to output data. Once the channel address is loaded, a positive going pulse on START will start the conversion and cause EOC to fall. When EOC goes high again the data is ready to be read, which, as was previously stated, is accomplished by raising the OE input. The data can be read any time prior to one clock period before the completion of the next conversion. The ADC0816/ADC0817 timing is shown in Figure 3. (See data sheet for exact specifications.)

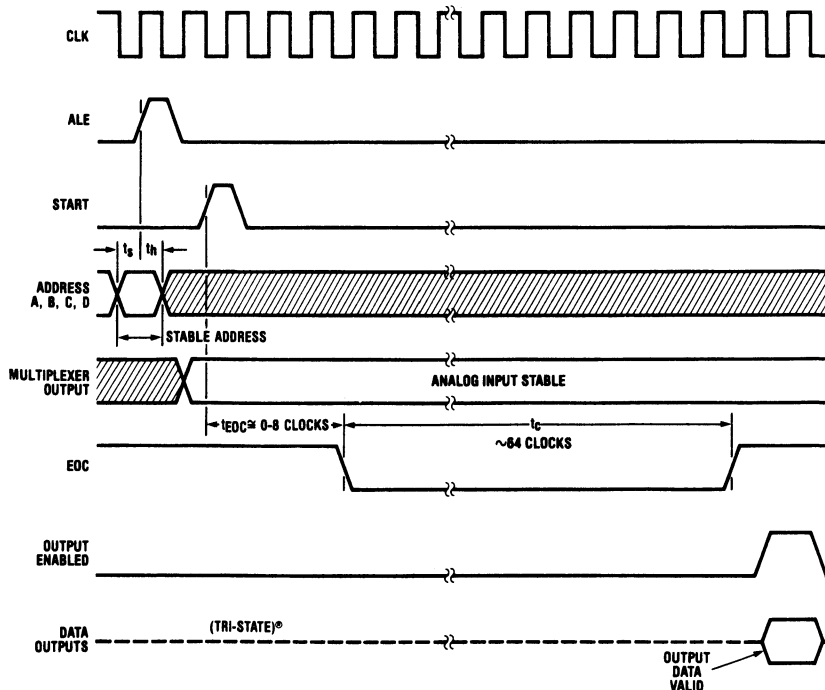


FIGURE 3. ADC0816/ADC0817 Timing Diagram

TL/H/5624-2

III. Analog Input Designs

A. Ratiometric Conversion

The external availability of both ends of the 256R resistor ladder makes this converter ideally suited to use with ratiometric transducers. A ratiometric transducer is a conversion device whose output is proportional to some arbitrary full scale value. In other words, the actual value of the transducers output is of no great importance, but the ratio of this output to the full scale reference is valuable. For example, the potentiometric transducers of *Figure 4* have this feature.

The prime advantage of these transducers is that an accurate reference is not required. However, the reference should be noise free because voltage spikes during a conversion could cause inaccurate results.

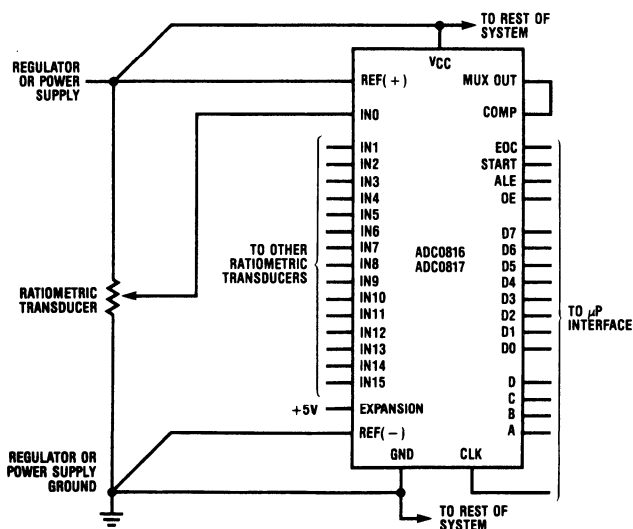
Perhaps the simplest method to obtain a reference would be to use a voltage already present in the system, the power supply. As shown in *Figure 4* the 5V supply can be easily connected as the reference, but care must be taken to reduce power supply noise. The supply lines should be well bypassed with filter capacitors and it is recommended that

separate PC board traces be used to route the 5V and ground to the reference inputs and to the supply pins.

B. Absolute Conversion

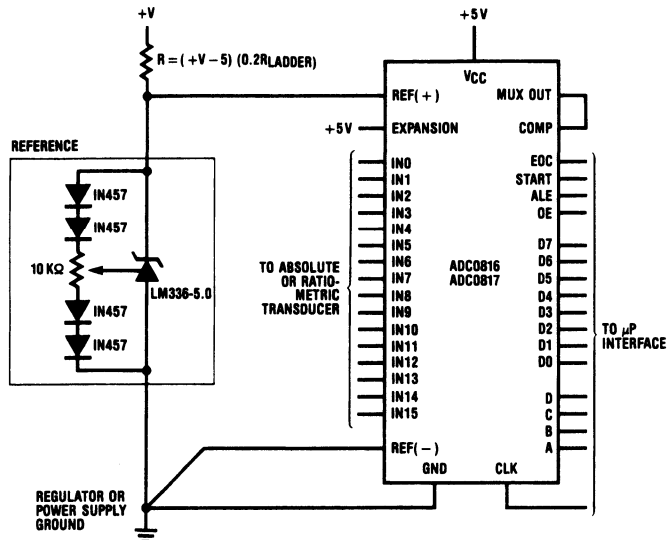
Absolute conversion refers to the use of transducers whose output value is not related to some other voltage. The "absolute" value of the transducer's output voltage is very important. This implies that the reference must be very accurately known to be able to accurately determine the value of the transducers output. *Figure 5* shows a typical grounded reference connection using the LM336-5, 5V reference. Note that ratiometric transducers can also be used in this application along with absolute transducers.

In most of the following applications either absolute or ratiometric transducers can be used. The only difference being that when absolute transducers are employed, more accurate references should be used.



TL/H/5624-3

FIGURE 4. Simple Ratiometric Converter Using Power Supply as Reference



TL/H/5624-4

FIGURE 5. Simple Absolute Converter Using LM336-5.0 Converter

C. Reference Manipulation

In some small systems (particularly CMOS systems) where a reference is required, one can use the reference as a supply as shown in Figure 6. In this case the LM336-5 is used to generate the 5V reference and also the 5V supply. An unregulated supply greater than 5V is required to allow the reference to operate. The series resistor, R, is chosen such that the maximum current needed by the system is supplied while keeping the LM336-5 in regulation. The value of this resistor is simply:

$$R = \frac{V_S - V_{REF}}{I_{LAD} + I_{TR} + I_p + I_R}$$

where V_S = unregulated supply voltage; V_{REF} = reference voltage; $I_{LAD} = V_{REF}/1 \text{ k}\Omega$, resistor ladder current; I_{TR} = transducer currents; I_p = system power supply requirements; and I_R = minimum reference current.

Figure 7 shows a simple method of buffering the references to provide higher current capabilities. This eliminates the I_p term in the above equation. In Figures 5, 6, and 7, it is advisable to add some supply bypass capacitors to reduce noise, typically 0.1 μF .

D. Reference Voltage Variation

In some cases it is possible to eliminate the need for gain adjustments on the analog input signals by varying the Ref(+) and Ref(-) voltages to achieve various full scale ranges. The reference voltage can be varied from 5V to about 0.5 volts with the one restriction that $[V_{Ref(+)} - V_{Ref(-)}]/2 = (V_{CC} - GND)/2 \pm 0.1$ volts. In other words, the center of the reference voltage must be within $\pm 0.1\text{V}$ of mid-supply. The reason for this is that the reference ladder is taped by an n or p-channel MOSFET switch tree. Offsetting the voltage at the center of the switch tree from $V_{CC}/2$ will cause the transistors to incorrectly turn off, resulting in inaccurate and erratic conversions. However, if

properly applied, this method can reduce parts counts as well as eliminate extra power supplies for the input buffers.

Figure 8 shows a simple supply centered reference where R1 and R2 offset Ref(+) and Ref(-) from V_{CC} and Ground. An LM336, 2.5V reference is shown here, but any reference between 0.5V and 5V can be used. For odd reference values the simple op amp scheme shown in Figure 9 can be used. Single power supply op amps such as the LM324's or LM10's would work well. R1, R2, and R3 form a resistor divider in which R1 and R3 center the reference at $V_{CC}/2$ and R2 can be varied to obtain the proper reference magnitude.

E. Analog Channel Expansion

The ADC0816/ADC0817 have an expansion control (EC) pin which is actually a multiplexer enable. When this signal is low, all the switches are inhibited so that another signal can be applied to the comparator input. Additional channels can be implemented very simply, as shown in Figure 10. This design has expanded the number of channels from 16 to 32. To address the channels, 5 address lines are required. The lower 4 bits are directly applied to the A/D's A, B, C, and D inputs. All 5 bits are also applied to an MM74C174 Hex "D" flip-flop which is used as an address latch for the two CD4051's. The 1Q, 2Q, and 3Q outputs of the MM74C174 feed the CD4051 address inputs 4Q and 5Q are gated to form enable signals for each CD4051. 5Q is also routed to the EC input to properly enable the A/D's multiplexer.

The CD4051s are used with a 5V supply, so their specifications are very similar to the ADC0816/ADC0817 multiplexer. Thus, anything that can be done with the ADC0816/ADC0817 multiplexer can be done with the CD4051's. This includes making use of the previously discussed input designs as well as others.

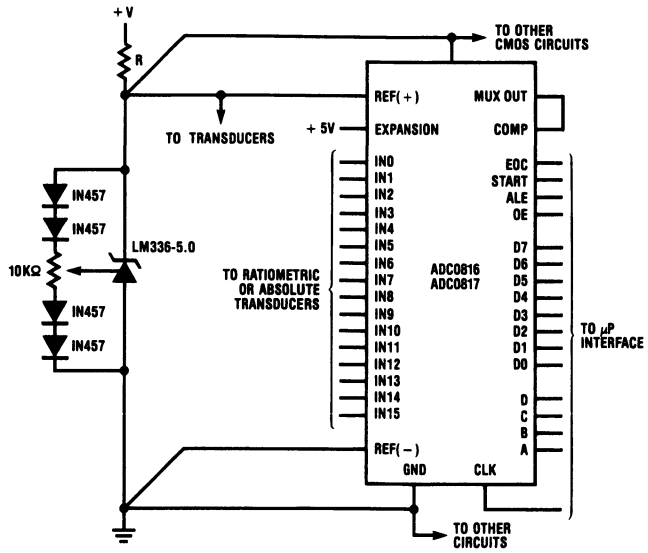


FIGURE 6. Reference Used as Power Supply

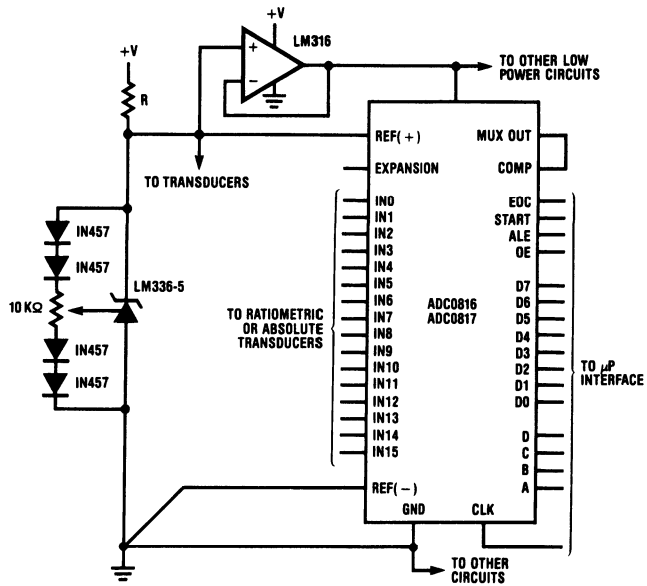


FIGURE 7. Buffered Reference Used as Power Supply

TL/H/5624-5

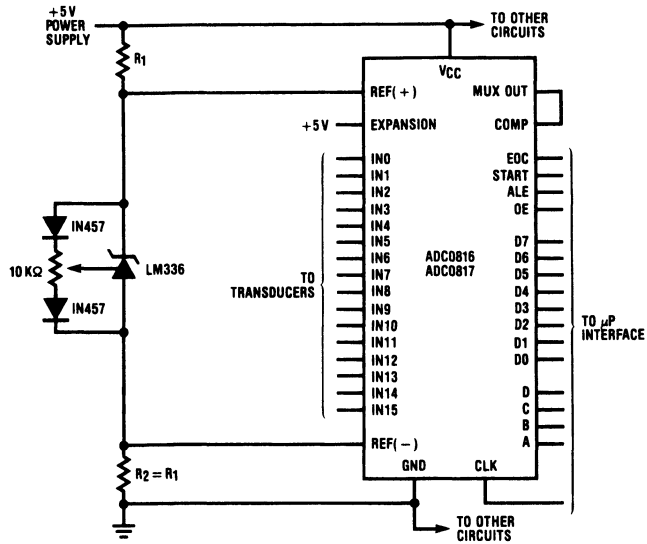


FIGURE 8. Supply Centered Reference Using LM336 2.5V Reference

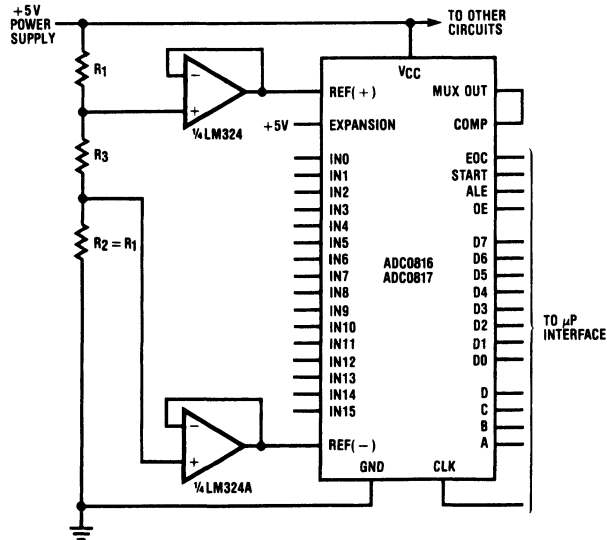


FIGURE 9. Supply-Centered Reference Using Buffered Resistor Divider

TL/H/5624-6

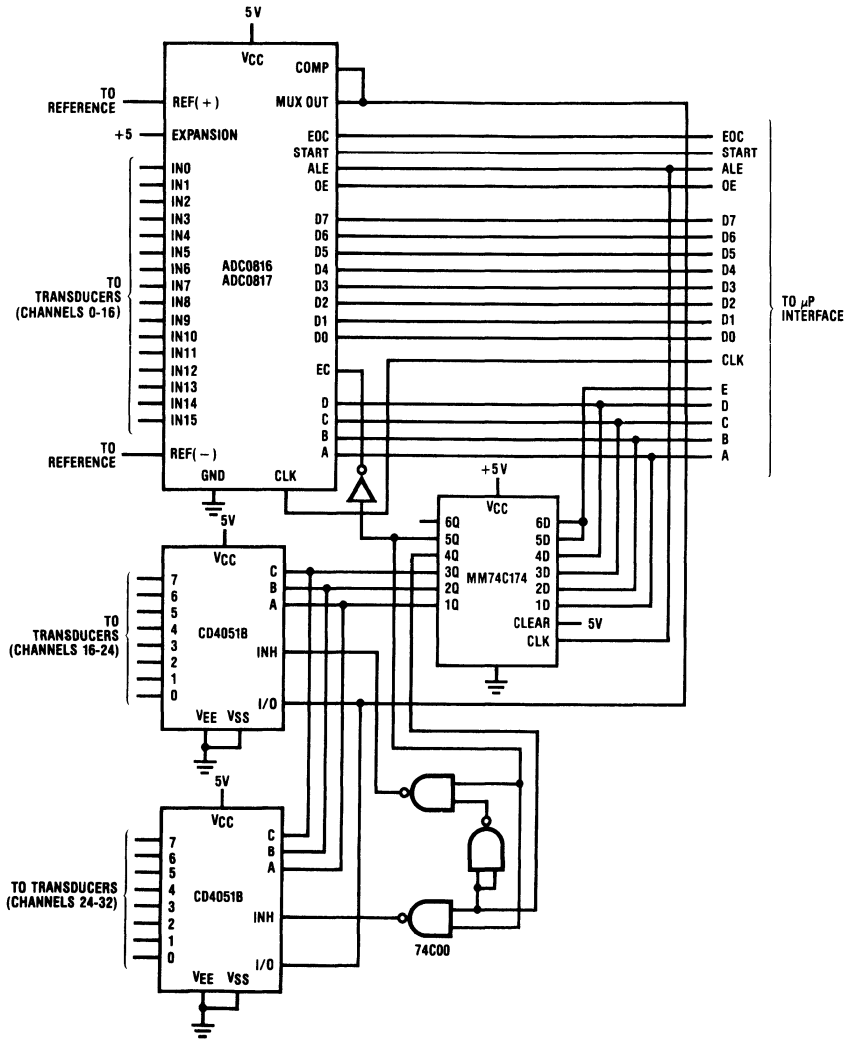
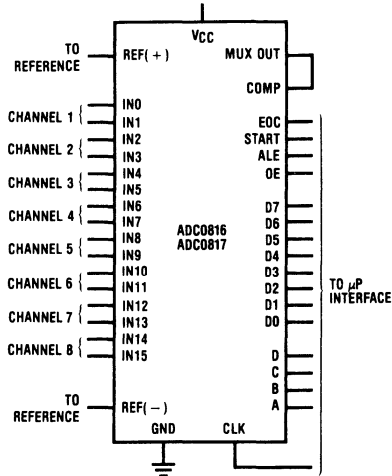


FIGURE 10. Simple 32-Channel A/D Converter

TL/H/5624-7

F. Differential Analog Inputs

An easy, and sometimes overlooked method for implementing a differential input scheme is shown in *Figure 11*. This approach actually implements the differential in software. All 16 channels are paired into positive and negative inputs. Then the controlling logic or microprocessor will convert each channel of a differential pair, load each result, and then subtract the two results. This method requires two single ended conversions to do one differential conversion, hence the effective differential conversion time is twice that of a single channel or a little over 200 μs ($C_k = 640 \text{ kHz}$). The differential inputs should be stable throughout both of the conversions to produce accurate results.



TL/H/5624-8

FIGURE 11. Simple 8-Differential Channel Converter

A 16 channel differential system can be realized by modifying *Figure 10*. This is accomplished by changing the CD4051's addressing and adding a differential amplifier in between the multiplexer outputs and the comparator input. The select logic for the CD4051's has been modified to enable the switches to be selected in parallel with the ADC0816/ADC0817. The outputs of the three multiplexers are connected to a differential amplifier, composed of 2 inverting amplifiers with gain and offset trimmers. A dual op amp configuration of inverting amplifiers can more easily be trimmed and has less stringent feed-back resistor matching requirements, as compared to a single op amp design. The transfer equation for the dual op amp amplifier shown in *Figure 12* is:

$$V_o = \left[\frac{R_2 R_5}{R_1 R_3} \right] V_1 - \left[\frac{R_5}{R_4} \right] V_2$$

Propagation delay through the op amps should be considered to provide sufficient time between the analog switch selection and start conversion to allow the analog signal at

the comparator input to settle. Using the LF353 op amp, this delay should be about 5 μs .

G. Input Signal Buffering

There are three basic ranges of input signal levels that can occur when interfacing the ADC0816/ADC0817 to the "real world". These are: a) signals which exceed V_{CC} and/or go below ground; b) signals whose input ranges are less than V_{CC} and Ground, but are different than the reference range; c) and signals that have an input range that is equal to the reference range. Each of these situations require different buffering.

The last situation, case "c" is usually trivial. No buffering is required unless the source impedance of the input signal is very high. If this is the case a buffer may be added between the multiplexer output and comparator input pins. If a high input impedance op amp is used, the input leakage looking from the multiplexer input can be greatly reduced. This circuit is shown in *Figure 13*. Using a buffer like this eliminates the necessity for large capacitors on the multiplexer inputs (explained later), but these buffers usually require two supplies and can contribute their own conversion errors.

If the input signal is within the supply, but the reference cannot be manipulated to conform to the full input range, the unity gain buffer of *Figure 13* can be replaced by another op amp as shown in the *Figure 13* inset. This type of amplifier will provide gain and/or offset control to create a full scale range equal to the reference.

The third case, c, where the input range exceeds V_{CC} and/or goes below ground, the input signals must be level shifted before they can go to the multiplexer with the only exception being when the magnitude of the input voltage range is within 5V, but outside the 0-5V supply range. In this case the supply for the entire chip could be shifted to the analog input range, and the digital signals level shifted to the system's 5V supply.

A typical example would be bipolar inputs from -2.5V to $+2.5\text{V}$. If the ADC0816/ADC0817 have their supply and reference derived as shown in *Figure 14*, then the $\pm 2.5\text{V}$ logic outputs need only to be level shifted to 0 and 5V logic levels, *Figure 15*.

H. Digital Data Acquisition

The ADC0816/ADC0817 make good analog data acquisition subsystems, but there are many instances where these converters are good digital data acquisition systems as well. If a system has unused channels, digital inputs can be connected to these channels instead of being separately buffered into the system. In the case of a microprocessor system this could eliminate an I/O port and associated logic. The speed at which this input is accessed is one conversion cycle, but many times this will be fast enough. These inputs can be used as input switches, power supply indicator devices, or other system status flags. The microprocessor converts the digital input channel and reads it. Software then decides whether the input is high enough or low enough to cause a particular action.

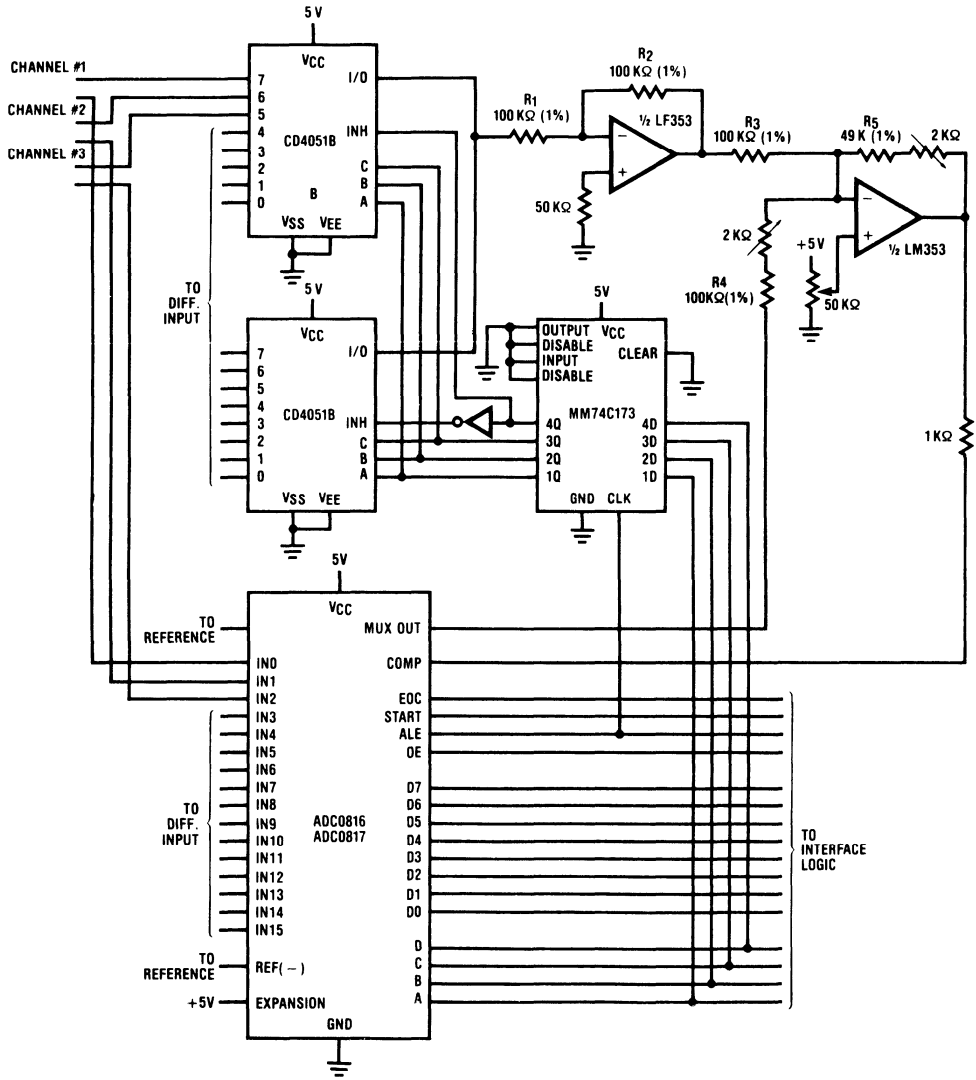


FIGURE 12. Differential 16-Channel A/D Converter

TL/H/5624-9

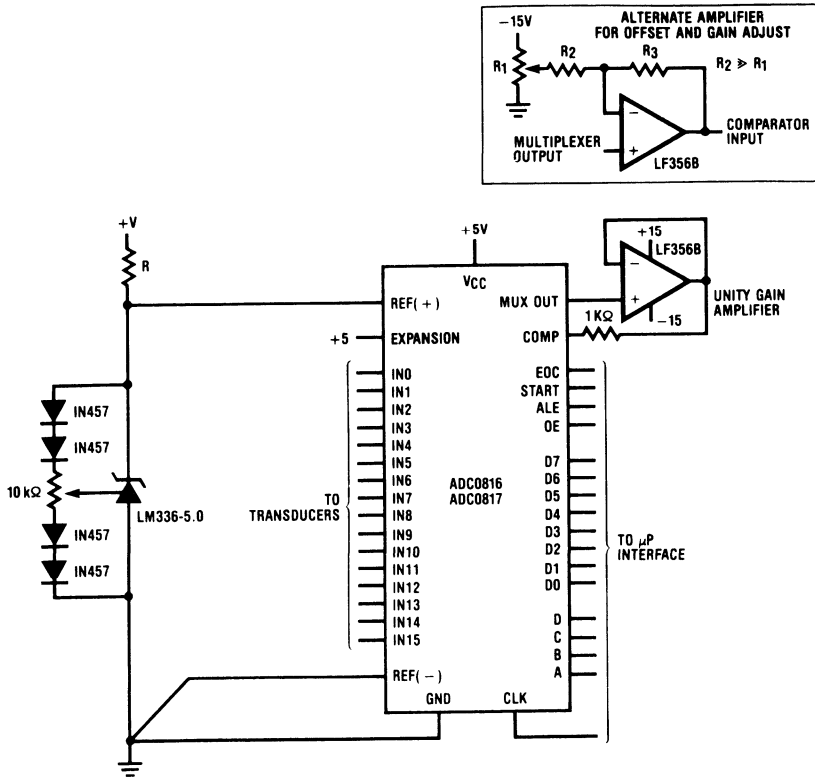


FIGURE 13. Single Input Amplifier Buffering

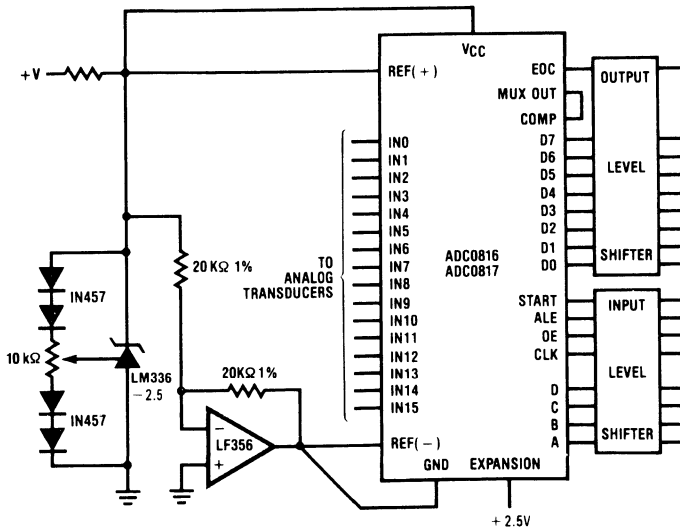


FIGURE 14. ±2.5V Input Range Data Acquisition

TL/H/5624-10

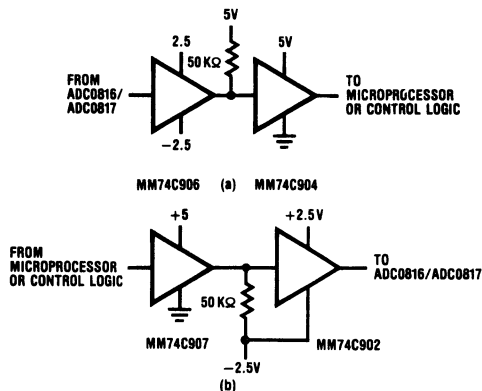


FIGURE 15. Input/Output Level Shifters

TL/H/5624-11

I. Input Considerations

In most instances interfacing analog circuitry is very straightforward, but there are some constraints that should be observed if a reliable accurate system design is to result. One major consideration, input source impedance is actually more complicated than it appears. One would expect that the input current would be a small D.C. current, but due to the nature of the comparator, it is not. The A/D's comparator is a capacitor sampling comparator whose input current is a series of spikes. Figure 16 shows a simplified model of the comparator input.

When determining a single bit value during a conversion, S1 will close causing C_C and C_p to charge to the input voltage. Then S1 is opened and S2 is closed sampling the ladder. The input current is an RC transient charging current whose magnitude and duration is dependent on the values of C_C , C_p , R_S , R_m and R_L . The duration of the transient must be shorter than the input sample period, and the sample period is dependent on the converter's clock frequency. Thus the maximum source impedance is dependent on the clock period. At a clock frequency of 1 MHz, $R_S \leq 1k$; and at 640 kHz, $R_S \leq 2k$. The source impedance of potentiometric transducers vary as a function of wiper position. Thus transducers with a value of $\leq 10k$ at a frequency of 640 kHz and $\leq 5k$ at 1 MHz are suitable.

When a sample-and-hold or some other active device is inserted between the multiplexer and comparator pins, the output impedance of the transducers are no longer as restricted and depend more on the particular Sample/Hold or op amp chosen. The critical parameter now is the source

impedance of the buffer which should be $\leq 3k$ at a clock frequency of 1 MHz and $\leq 5k\Omega$ with the clock equal to 640 kHz.

If higher impedances are unavoidable, RC charging errors can be reduced to an average current error by placing a capacitor = $1\mu F$, from the multiplexer input to ground. Adding this capacitor will average the transient current spikes and cause a small DC current error which for a potentiometric transducer is:

$$V_{ERR} = \frac{R_p}{8} (I_{IN}) \frac{C_k}{640 \text{ kHz}} \text{ Volts}$$

where R_p = total potentiometer resistance; $I_{IN} = 2\mu A$ (maximum input current at 640 kHz); and C_k = clock frequency. For a standard buffer source impedance the voltage error is:

$$V_{ERR} = I_{IN}(R_S) \frac{C_k}{640 \text{ kHz}} \text{ Volts}$$

where R_S = buffer source impedance; $I_{IN} = 2\mu A$ (maximum average input current at 640 kHz); and C_k = clock frequency.

In addition, whenever analog signals are present in a digital system, several precautions should be exercised to reduce noise on the analog inputs. The analog input signals and the reference input should be kept physically isolated from the digital signals and a single point analog ground should be employed.

J. Protecting the Analog Inputs Against Over Voltages

During normal operation, it is important to keep the analog input voltages to the multiplexer or comparator between V_{CC} and Ground to ensure proper operation. There may be some occasions where over or under voltages cannot be avoided. Protecting the analog inputs, due to their unique nature, can be more difficult than digital inputs. The most effective method is to use external Schottky diodes as shown in *Figure 17a*. Since the Schottky knee voltage is 0.4 volts the IN5166 diodes of *Figure 17a* will safely shunt currents up to several milliamps. To shunt possible currents larger than several milliamps some series resistance may

be added to limit these currents as shown in *Figure 17b*, but this value resistor must be no greater than the values specified in the previous section.

A less expensive solution would be to replace the Schottky diode with some standard switching diodes, *Figure 17b*, but since these diodes could only partially shunt the input current from the internal clamp diodes, some series resistor should be used as in *Figure 17c*. If the external diode must shunt a large amount of current the two series resistors of *Figure 17d* should be used. If the input design is such that the input can exceed only one supply the diode going to the other supply can be omitted.

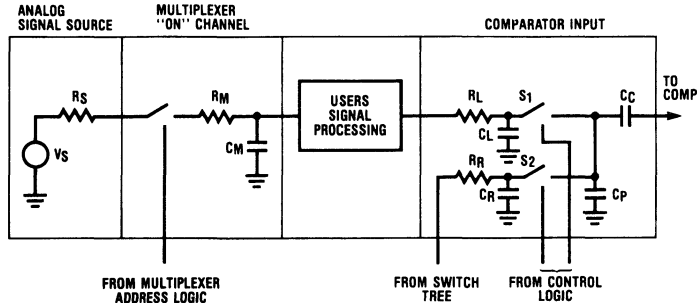


FIGURE 16. Simplified Multiplexer/Comparator Equivalent Circuit

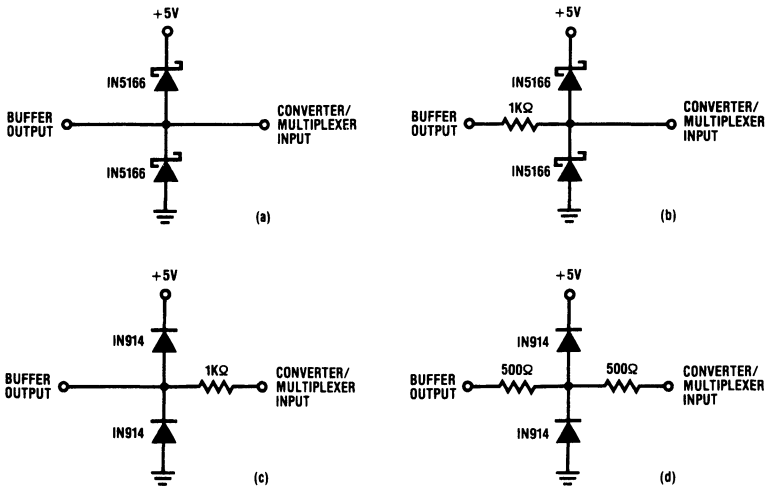


FIGURE 17. Analog Input Protection Circuitry

TL/H/5624-12

IV. Signal Conditioning

There are many applications where it is desirable to add some signal processing circuitry to improve circuit performance. Typical additions would be filter circuits, sample/holds, gain controlled amplifiers, and others. Here again the external accessibility of the multiplexer output and comparator input pins can greatly reduce the amount of circuitry required by enabling the use of only one circuit required by all 16 outputs instead of 1 for each input.

A. Gain Control

Previous examples of gain manipulation have dealt with one fixed gain for all 16 channels, but there are occasions where variable gain or selectable gain may improve accuracy and simplify hardware and/or software.

Figure 18 shows a typical method for gain control. The CD4051, analog multiplexer, is placed in the feedback loop of a simple non-inverting op amp. The gain of this op amp is controlled by selecting one of the CD4051's analog switches.

This will switch a resistor in and out of the feedback loop. If these resistors, R_{2N} , are of different values, different gains are realized. These gains are given by:

$$A_V = 1 + \frac{R_{2N}}{R_1}$$

A microprocessor or some control logic would select a gain by latching the channel address into a MM74C173. It is important to ensure the output of the LF356B does not exceed the power supply, so before a new channel is selected the gain of the op amp should be reduced to a safe value. The 1k resistor on the output of the LF356B is to help protect the comparator inputs from accidental over or under voltages. Two back biased diodes placed from the input to V_{CC} and Ground (IN914 or Schottky) will offer further protection.

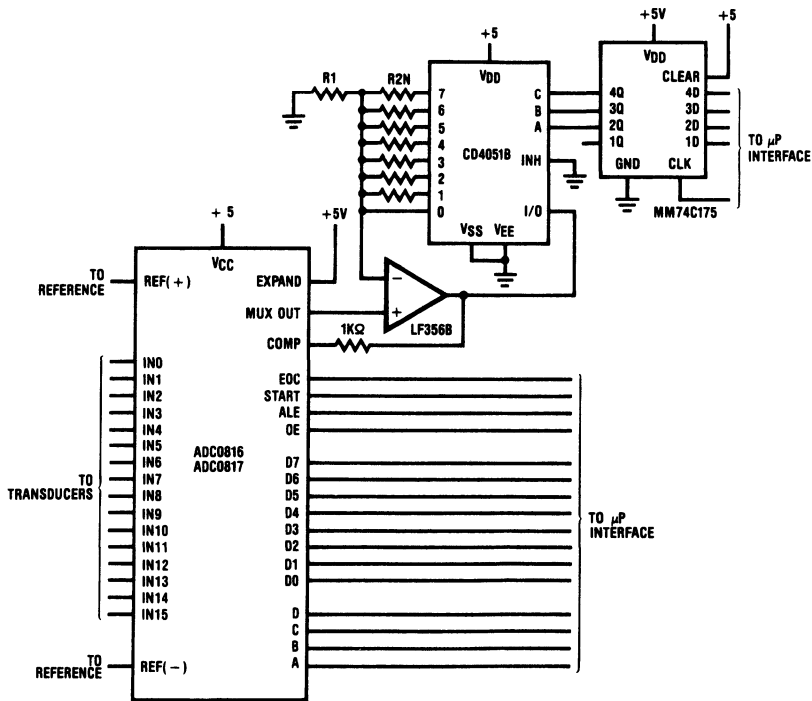


FIGURE 18. Microprocessor Controlled Gain

TL/H/5624-13

B. Sample/Holds

The only major data acquisition element not included on the ADC0816 is a sample/hold circuit. If the input signals are fast moving then a S/H should be used to quickly acquire the signal and then hold it while the ADC0816/ADC0817 converts it. This circuit can be easily implemented by inserting it between the multiplexer output and the comparator input.

The simplest solution is to tie a capacitor on the multiplexer output and then tie this pin to the comparator input pin. The expansion control pin is used as a sample control. When this pin is high one switch is on and the capacitor voltage will follow the input. However, when the expansion control pin is pulled low, all switches are turned off and the capacitor holds its last value, almost. The input bias to the comparator is about $2 \mu\text{A}$ (worst case with $C_k = 640 \text{ kHz}$). Thus the droop rate for a 1000 pF is approximately 2000 V/S or about 0.2 V/conversion . This is totally impractical. If a $0.01 \mu\text{F}$ capacitor is used instead then the droop rate is 20 mV , which may be satisfactory. Unfortunately, the acquisition time is on the order $100 \mu\text{S}$, or about the length of a conversion.

The problem is that the comparator input leakage is too high for this sample and hold. To eliminate this, the input can be buffered by using an LM356B. *Figure 19*. The leakage, now due mostly to multiplexer leakages, is reduced to approximately 100 nA . The droop per conversion is typically less than 1.0 mV per conversion when using a 1000 pF capacitor and the acquisition time is approximately $20 \mu\text{S}$.

A more accurate solution would be to isolate the capacitor from both the multiplexer comparator pins of the ADC0816/

ADC0817. This is easily accomplished by using the LF398 monolithic sample/hold, as shown in *Figure 20*. The acquisition time for this part is typically $4 \mu\text{S}$ to 0.1% , and the droop rate is $20 \mu\text{V/conversion}$. This circuit has its own hold control thus the expansion control is free to be used normally.

The choice of the hold capacitor is critical to the performance of the sample/hold circuit. Some capacitors are composed of dielectrics that will have an initial droop after the hold is strobed. This is due to dielectric absorption. Polypropylene and polystyrene dielectrics have very little dielectric absorption and thus make excellent sample/hold capacitors. Such materials as mylar polyethylene have higher absorption properties and should not be used.

C. Filtering Analog Inputs

Under some conditions the analog input may have come from a noisy environment and to recapture the original signal some filtering may be required. Typically high frequency noise must be filtered. The ADC0816/ADC0817 can easily accommodate the addition of many standard low pass filters. Another useful filter is a 50 Hz or 60 Hz notch filter to eliminate the noise contributed to the circuit by A.C. power lines.

It is particularly easy to place a single passive filter between the multiplexer output and comparator input pins, but passive filters must be carefully designed to reduce input loading. The filter capacitor will tend to average the comparator sampling current as mentioned in the Input Considerations section. To eliminate this, the passive filter can be buffered by an op amp or an active filter could be used.

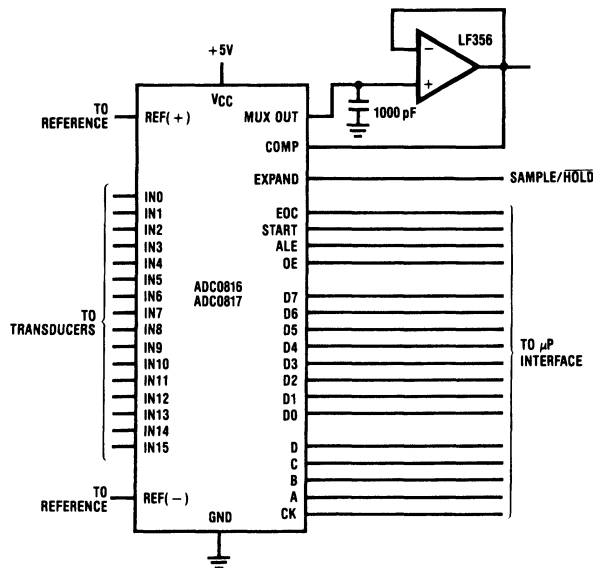


FIGURE 19. Op Amp Sample Hold Circuit

TL/H/5624-14

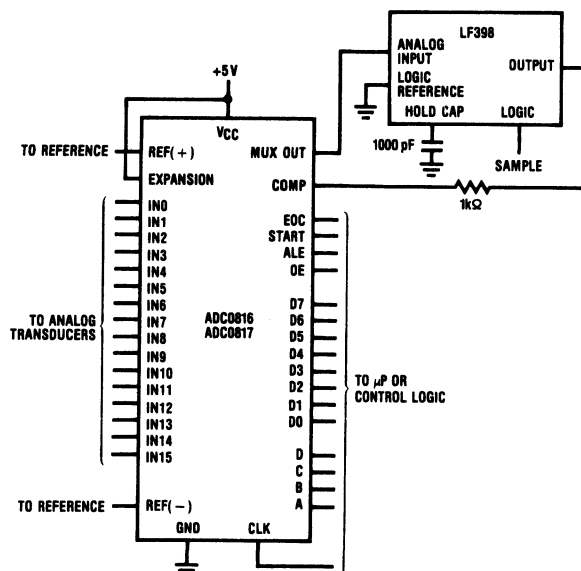


FIGURE 20. Sample/Hold Converter Using LF398

TL/H/5624-15

V. Microprocessor Interface

The interface requirements for the ADC0816/ADC0817 interconnection to various microprocessors are essentially the same as the ADC0808/ADC0809 requirements. The devices can be connected to the CPU so that it looks either like a memory location or I/O port. The data transfers can be initiated by either an interrupt to the CPU or the CPU can periodically interrogate the A/D. When trying to implement an absolute minimum components count system, the I/O port (as opposed to memory) addressing will usually require fewer components.

There are several design considerations that apply to most microprocessor systems when interfacing the ADC0816/ADC0817. Even though the actual timing of CPU read and write cycles vary, in general, a microprocessor will output the address and data (if write operation) onto its busses. A certain time later the Read or Write strobes will go active for a specified time. The interface logic must detect the state of the address and data busses and initiate the specified action. For the ADC0816/ADC0817 these actions are: 1) load channel address, 2) start conversion, 3) detect end of conversion and 4) read resultant data. These actions are performed by decoding the read/write strobes, address, and data information to form the and ALE and START pulses, then detect EOC, and finally read the data.

For the most part the decoding and strobe generation is straight forward. The START, ALE, and OE strobes will generally be of the same duration as the CPU read/write strobes and positive going (ALE can be negative going). One subtle choice is where to derive the A, B, C, and D channel select address. These lines can be connected to either the address bus or the data bus. The advantage of connecting them to the data bus is that in minimum systems, more I/O address lines are available for simple decoding. When the A, B, C, and D inputs are connected to the address bus each analog channel becomes a separate I/O port.

In most designs it is very tempting to tie START and ALE together, enabling one pulse to both write the channel address and then start the conversion. However, it is very important that the signal on the comparator input be stable before the conversion starts, otherwise the first and most important successive approximation could be in error. Usually the START and ALE pulses are the same length as the CPU read and write strobes which are normally between 0.2 to 1. μ S long. Thus the conversion may start within 1 μ S of the address select latching. (Remember the channel is selected on the rising edge of ALE and the conversion begins within 8 clock periods of the falling edge of START.) For converter clocks greater than 500 kHz, 1 μ S may not be enough time to allow the analog input signal to propagate through the multiplexer and any additional signal conditioning circuitry such as buffers, S/H's, etc. There are, however, a couple of easy fixes that can correct this possible problem. First, the START/ALE pulse could be stretched to the proper length by using a one-shot (MM74C221 or similar) to generate a pulse as long as the total delay from multiplexer input to comparator input. Secondly, the problem can be circumvented by "double pulsing" the converter. This can be easily accomplished in software by writing to the START/ALE address twice. The first pulse latches the desired channel address and starts the conversion. The second pulse must again load the same channel address, which will not change the multiplexer's state, and will then restart the conversion. Of course, the second pulse must occur after the comparator input has settled.

Even though the hardware to interface the ADC0816/ADC0817 to various microprocessors will differ and the system software will vary, the basic routines to operate the ADC0816/ADC0817 are usually similar. There are many variations, but *Figures 21 & 22* illustrate flow charts that typify these routines. The ADC0816/ADC0817 is tied directly

to the address and data bus (as opposed to using a peripheral controller). Generally, the hardware to create START and ALE pulses. This does not necessarily have to be true, but write instructions are conceptually easier and little is gained by designing the logic such that read instructions initiate these pulses. The OE pulse must be created by an I/O or memory read as the converter's data must be read.

The major design consideration is whether EOC should be polled by the microprocessor or whether EOC should cause an interrupt. This decision is system dependent, however the following applications illustrate both methods.

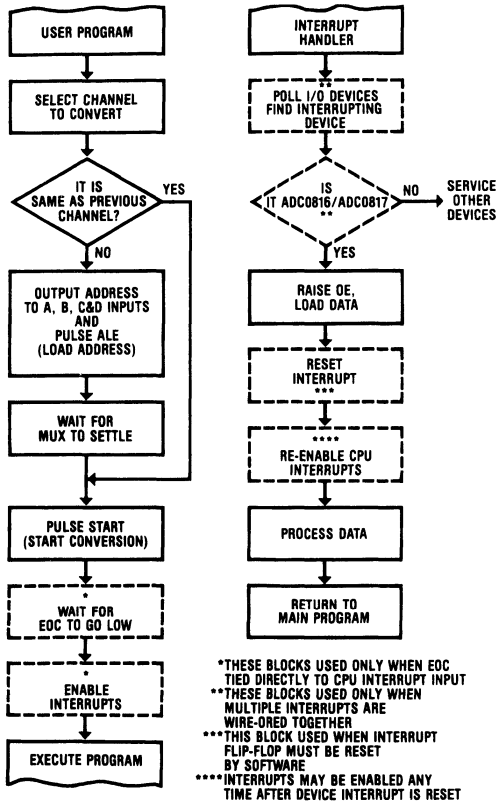


FIGURE 21. Flow Chart for Interrupt Control of ADC0816/ADC0817

A. Interfacing to INS8080

Interfacing the ADC0816/ADC0817 to an INS8080 system is extremely simple, because the INS8080/INS8224/INS8228 CPU group have separate I/O read ($\overline{I/O\overline{R}}$) and I/O write ($\overline{I/O\overline{W}}$) strobes which imply that the INS8080 has separate I/O addressing. In small systems this means that very little or no address decoding is necessary. Figure 23 shows a very simple interface which uses two NOR gates to gate the I/O strobes with the most significant address bit A7. The INS8080 has 8 bits of port address which will yield a maximum of 4 I/O ports if inputs A, B, C, and D are connected to the address bus. A MM74C74 flip-flop is used as a divide-by-2 to generate a converter clock of 1 MHz. If the INS8080 system clock is ≤ 1 MHz this flip-flop is unnecessary.

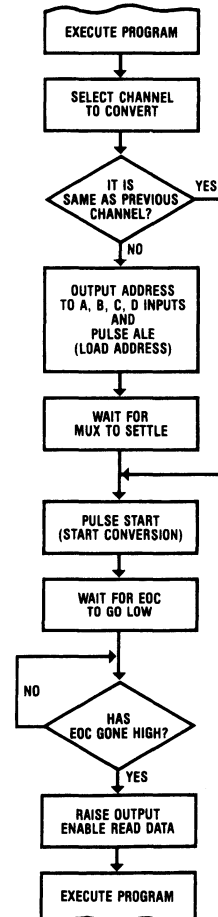


FIGURE 22. Flow Chart to Control ADC0816/ADC0817 in a Polled I/O Mode

TL/H/5624-16

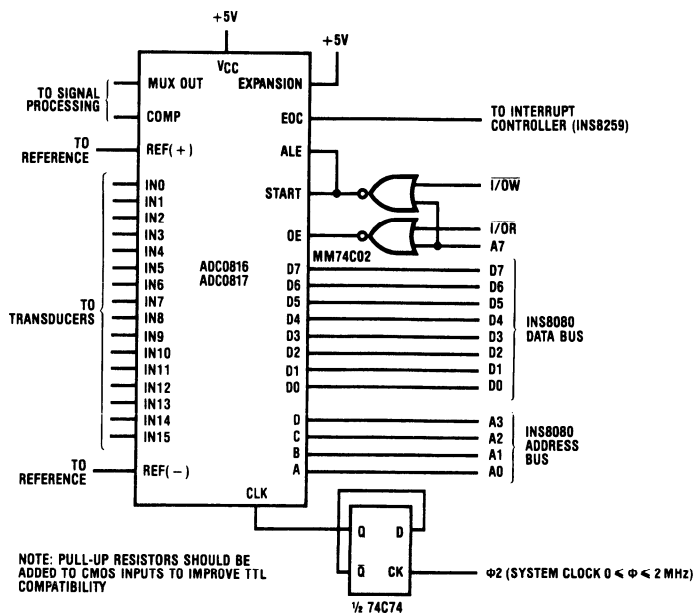


FIGURE 23. Simple INS8080/8224/8228 to ADC0816/ADC0817 Interface

TL/H/5624-17

Typical software would first write the channel address to the converter and start it. As mentioned before, two start pulses should be sent to the ADC0816/ADC0817 to allow the comparator input to settle. After the second start pulse the CPU could execute other program segments until it is interrupted by EOC going high. Depending on the interrupt structure, program control would then be given to the interrupt handler which reads the converter's data.

The second interface circuit, *Figure 24* utilizes a DM74LS139 dual 2-4 decoder in which one-half of the chip is used to create read pulses and the other half write pulses. The START and OE inputs are inverted to provide the correct pulse polarity. This interface partially decodes A6 and A7 to provide more I/O capabilities than before. This circuit also implements a simple polled I/O structure. The EOC output is placed on the data bus by a TRI-STATE inverter when the inverter is enabled by an INS8080 read.

B. Interfacing to the Z80®

The Z80, even though architecturally similar to the INS8080, uses slightly different control lines to perform I/O reads and writes. In *Figure 25* a NOR gate approach similar to *Figure 22* is shown to interface the Z80 to the ADC0816/ADC0817. Instead of $\overline{I/O}R$ and $\overline{I/O}W$ strobes the Z80 has \overline{RD} (read) and \overline{WR} (write) strobes which are gated with \overline{IOREQ} (I/O request). In the Z80 interface, START is connected to OE instead of ALE. This will cause a new conversion to be started whenever the

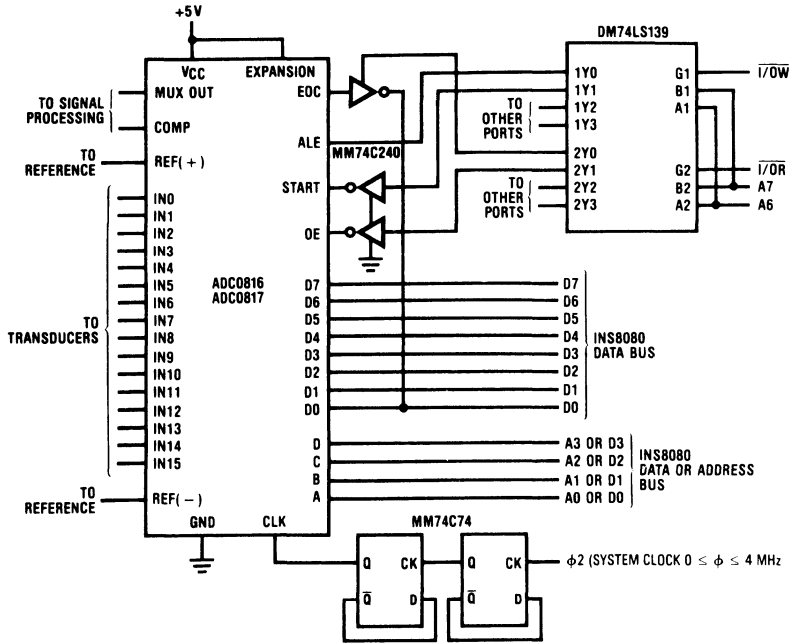
data is read which may seem unusual, but can actually be useful if the converter is to be continually restarted upon completion of the previous conversion. Address bit A6 is used to derive a strobe which will place EOC on the data bus to be read by the CPU.

Figure 26 uses a 6 bit comparator to decode A4-A7 and \overline{IOREQ} . Two NOR gates are used to gate the ALE/START and OE pulses. This design functions the same as *Figure 23* except that the DM8131 provides much more decoding.

C. Interfacing to the NSC800

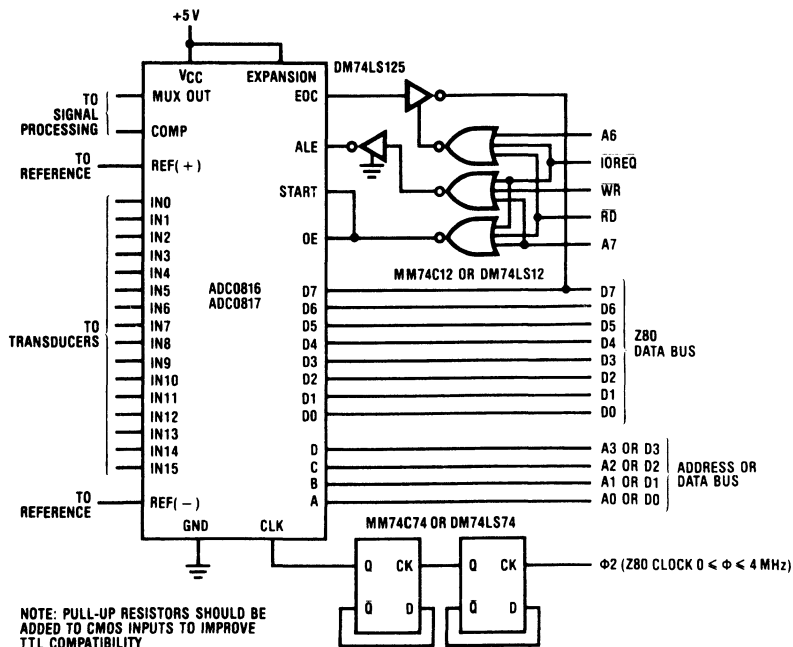
The NSC800 interface is actually very similar to the INS8080 I/O interface, even though their timing is very different. The NSC800 multiplexes the lower 8 address bits on the data bus at the beginning of each cycle. When accessing memory, A0-A7 must be latched out at the beginning of a read or write cycle, but for I/O accessing; the NSC800 duplicates the 8 bit I/O addresses on A8-A15 address lines and latches are not necessary since these lines aren't multiplexed. The I/O read and write strobes are derived from a \overline{RD} (read) and \overline{WR} (write) line and the $\overline{IO/M}$ signal.

Figure 27 shows a design using a dual 2-4 line decoder which decodes A15, and A14 and is enabled by the read/write strobes. TRI-STATE inverters are used to implement a scheme similar to *Figure 24*. This scheme has START and ALE accessed separately so that "double pulsing" isn't required.



NOTE: PULL-UP RESISTORS SHOULD BE ADDED TO CMOS INPUTS TO IMPROVE TTL COMPATIBILITY

FIGURE 24. Partial Address Decoding INS8080/8224/8228 to ADC0816/ADC0817



NOTE: PULL-UP RESISTORS SHOULD BE ADDED TO CMOS INPUTS TO IMPROVE TTL COMPATIBILITY

FIGURE 25. Simple Z80 Interface to ADC0816/ADC0817

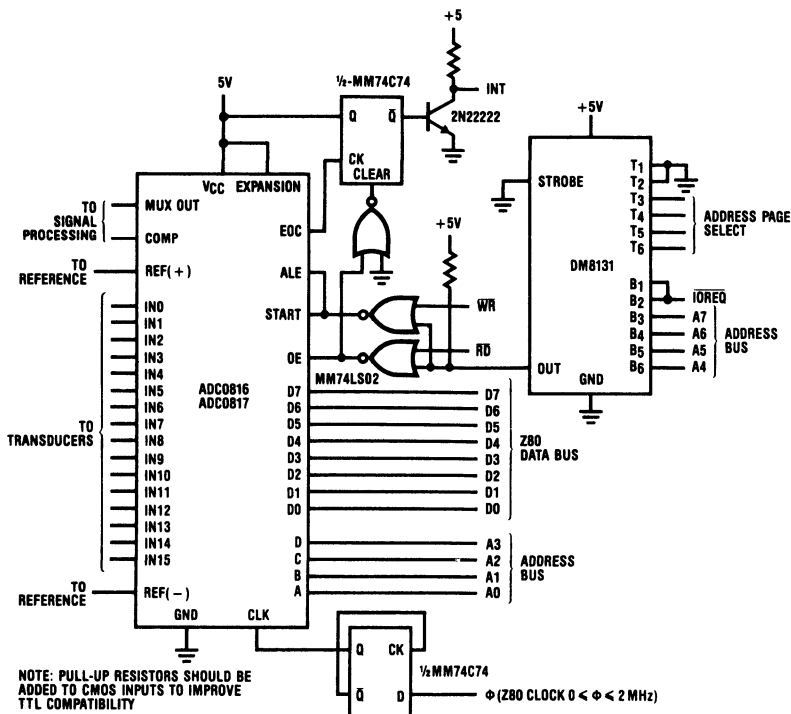


FIGURE 26. Decoded Z80 Interface

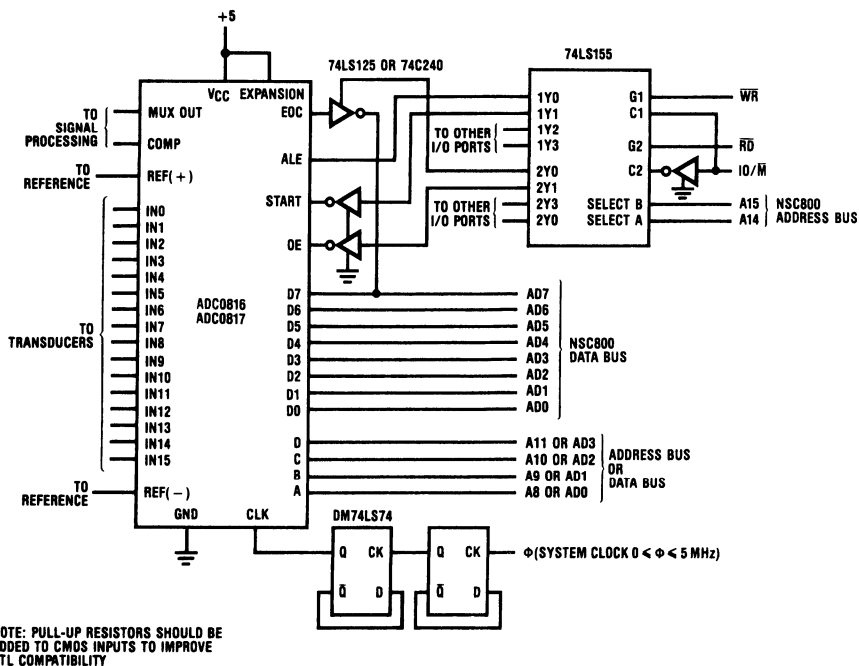


FIGURE 27. Partially Decoded NSC800 to ADC0816/ADC0817 Interface

The next design, *Figure 28*, uses the same simple NOR gating scheme as *Figure 23*, except the NSC800 control signals are slightly different. A simple interrupt scheme for EOC is employed using an MM74C74. When EOC goes high the flip-flop is set and $\overline{\text{INTR}}$ goes low. When the NSC800 acknowledges the interrupt by lowering $\overline{\text{INTA}}$, the flip-flop will reset. If more than one interrupt can occur simultaneously either $\overline{\text{INTA}}$ should be gated with EOC, or some other signal instead of $\overline{\text{INTA}}$ must be used. This is required since it is possible for the NSC800 to detect another interrupt and clear the ADC0816/ADC0817 interrupt before it's detected.

D. Interfacing to the 6800

The 6800 has no separate I/O addressing capabilities, so the system I/O must be addressed as though it is memory. As mentioned before, memory mapping can require more address decoding in order to separate memory from I/O, but in small systems very minimal parts count is still attainable.

Figure 29 illustrates an interface which uses a DM8131 comparator to partially decode the A12, A13, A14, and A15 address lines with the ϕ_2 clock and Valid Memory Address (VMA), to provide an address decode pulse for the two NOR gates which in turn generate the START/ALE Pulse and the output enable signal. This design will locate the A/D in one 4k byte block.

This design tied EOC to $\overline{\text{IREQ}}$ interrupt through an inverter. This is only usable in single interrupt systems since the 6800 has no way of resetting this interrupt except by

starting a new conversion. Since EOC is directly tied to the interrupt input, the controlling software must not re-enable interrupts until 8 converter clock periods after the START pulse when EOC is low.

The memory control signals are very different from the INS8080 type CPU's. One line indicates whether the operation is a read or write, R/W instead of separate read/write outputs on the INS8080/Z80/NSC800. This signal along with VMA indicates a valid read/write operation.

Figure 30 is slightly more complex, but provides more I/O port strobes. A NAND gate and inverter are used to decode the addresses, VMA and ϕ_2 clock. The I/O addresses are located at 11110XXXXAABBBB (Binary); where X= don't care; A=00 (Binary) for ALE write or IREQ reset/EOC read and A=01 for START write or Data read; and B= channel select address if A, B, C and D are connected to the address bus and ALE is accessed. A dual 2-4 line decoder is used to generate these strobes and inverters are used to create the correct logic levels.

The 6800 supports only a wired-OR interrupt structure. In a multi-interrupt environment only one interrupt is received and the interrupt handler routine must determine which device has caused the interrupt and service that device. (Although the INS8080/Z80/NSC800 can implement a similar structure, hardware interrupt controllers can also be used which will automatically vector the μP to the correct service routine.) To do this EOC is brought out to the data bus so the CPU can check it.

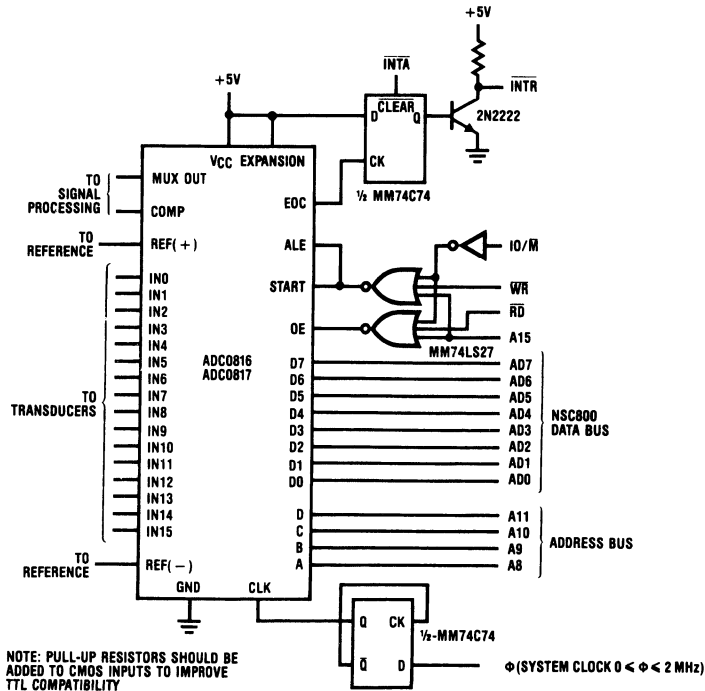


FIGURE 28. Minimal NSC800 to ADC0816/ADC0817 Interface

TL/H/5624-20

F. Parallel Interface Circuits

In some cases μ P support chips can be used to interface the ADC0816/ADC0817 to microprocessors. Most parallel I/O chips can be used, and provide enough flexibility to enable all functions to be under software control. Typical parallel I/O chips that could be used are INS8255, 6820, Z80-PIO and others. Typically these support IC's would be connected directly to the data and control pins and the software would manipulate the START and ALE pins via the interface chip. In some cases the chips provide handshaking and/or interrupt capabilities which can ease the converter interface. In some cases, the interface circuits will not provide a clock, and therefore must be provided externally.

While use of parallel I/O circuits simplify designs and increase versatility, they are more expensive than the 1 or 2

SSI or MSI circuits that they would replace, and thus not always the best choice.

VI. Conclusion

The ADC0816/ADC0817 are easy to use general purpose A/D converters with the additional benefit of a 16 channel analog multiplexer. The IC's can become a simple standard 8-bit data acquisition circuit or the basis of a more powerful data acquisition system. Both integrated circuits provide features to enable easy microprocessor interface, yet also allow hardwired control logic to be used. In those applications which require less accuracy, the less expensive ADC0817 can be used to reduce overall system cost.

A 20-Bit (1 ppm) Linear Slope-Integrating A/D Converter

National Semiconductor
Application Note 260



By combining an "inferior", 20 year old A/D conversion technique with a microprocessor, a developmental A/D converter achieves 1 part-per-million (20-bit) linearity. The absolute accuracy of the converter is primarily limited by the voltage reference available. The precision achieved by the unlikely combination of technologies surpasses conventional approaches by more than an order of magnitude. The approach used points the way towards a generation of "smart" converters, which would feature medium to high resolution (12 bits and above) with high accuracy over extended temperature range. The conversion technique employed, while slow speed, suits transducer based measurement systems which require high resolution over widely varying conditions of time and temperature. In addition, extensions of the basic converter have achieved 15-bit digitization of signal inputs of only 30 mV full-scale with no sacrifice in linearity or stability. This offers the prospect of an "instrumentation converter" which could interface directly with low level analog signals.

One of the many A/D techniques utilized in the late 50's and early 60's was the single-slope-integrating converter. One form of this circuit compares a linear reference ramp to the unknown voltage input (see About Integrating Converters and Capacitors). When the ramp potential crosses the unknown input voltage a comparator changes state. The length of time between the start of the ramp and the comparator changing state is proportional to the input voltage. This length of time is measured digitally and presented as the converter output. The inherent strengths of this type of converter are simplicity and high linearity. Although single-slope-integrators were used in early A/Ds and voltmeters their dependence on an integrating capacitor for stability was considered an intolerable weakness. The advent of the dual-slope converter (see About Integrating Converters and Capacitors) solved the problem of integrating capacitor drift with time and temperature by error cancellation techniques. In a dual-slope converter the output represents the ratio of the time required to integrate the unknown voltage for a fixed time and then, using a reference voltage of opposing polarity, measures the amount of time required to get back to the original starting point (see About Integrating Converters and Capacitors). The technique eliminates capacitor drift as an error term.

Limitations of Dual-Slope Converters

The dual-slope converter, and variants on it, have been refined to a point where 16 and 17-bit resolution units are available. A primary detriment to linearity in these converters is a parasitic effect in capacitors called dielectric absorption. Dielectric absorption can be conceptualized as a slight hysteresis of response by the capacitor to charging and discharging. It is influenced by the recent history of cur-

rent flow in the capacitor, including the magnitude, duration and direction of current flow (see About Integrating Converters and Capacitors).

The nature of operation of dual-slope and related converters requires the instantaneous reversal of current in the integrating capacitor. This puts a substantial burden on the dielectric absorption characteristics of the capacitor. Although dual-slope and related techniques go far to cancel zero and full-scale drifts, residual non-linearity exists due to the effects of dielectric absorption. In addition to non-linearity, dielectric absorption can also cause the converter to give different outputs with a fixed input as the conversion rate is varied over any significant range. Various compensation arrangements are employed to partially offset these effects in present converters. What is really needed for high precision, however, is a conversion scheme which inherently acts to cancel the effects of dielectric absorption, while simultaneously correcting for zero and full-scale drifts.

Overcoming Dual-Slope Limitations

Figure 1 diagrams a converter which meets the requirement noted previously. In this arrangement a microprocessor is used to sequentially switch zero, full-scale reference and EX signals into one input of a comparator. The other comparator input is driven from the ramp output of an operational amplifier integrator. With no convert command applied to the microprocessor, the circuit is at quiescence. In this state the microprocessor sends a continuous, regularly spaced signal to the integrator reset switch. This results in a relatively fixed frequency, period and height ramp at the amplifier's output. This relationship never changes, regardless of the converter's operating state. In addition, the time between ramps is lengthy, resulting in an effective and repeatable reset for the capacitor. When a convert command is applied, the microprocessor switches the comparator input to the zero position, waits for the next available ramp and then measures the amount of time required for the ramp to cross zero volts. This information is stored in memory. The microprocessor then repeats this procedure for the full-scale reference and EX switch positions. With all this information, and the assumption that the integrator ramps are highly linear, the absolute value of EX is determined by the processor according to the following equation.

$$EX = \frac{[C_{EX} - C_{ZERO}]}{[C_{FULL-SCALE} - C_{ZERO}]} \times K \mu V$$

where C = count obtained

and K = a constant, typically 107

After this equation is solved and the answer presented as the converter's output, the conversion is complete and the microprocessor is ready to receive the next convert command.

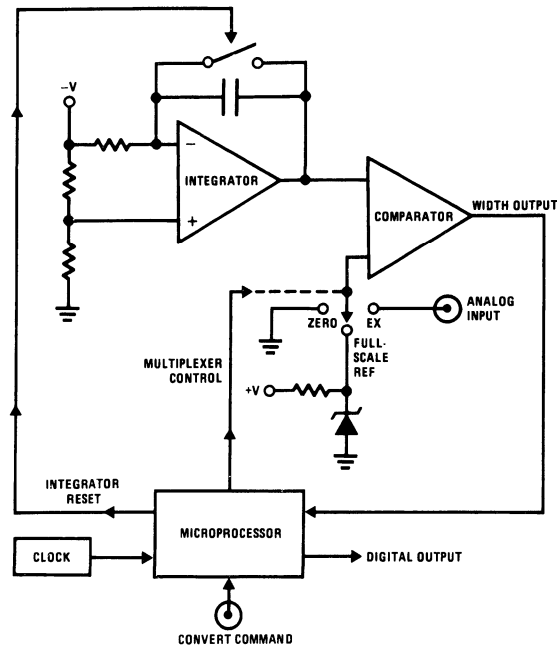


FIGURE 1

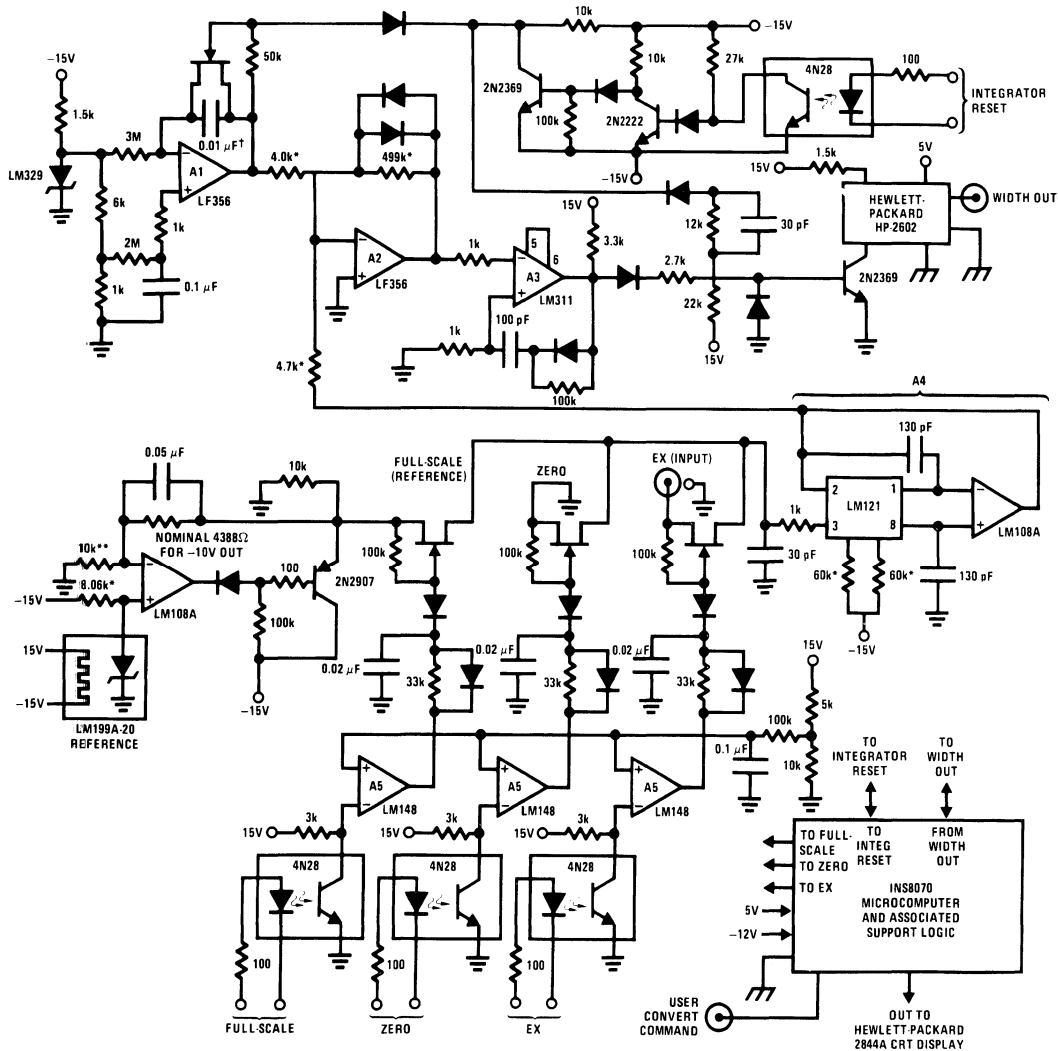
TL/H/5625-1

The converter arrangement shares many of the characteristics of a dual-slope type and also provides some significant advantages. The key operating features are as follows:

1. It continuously corrects for zero and full-scale drift in all components in the A/D circuit, regardless of changes in time or temperature. The primary limitation on accuracy is the stability of the full-scale reference. The zero signal is derived through conventional high quality grounding technique. These features are similar to a dual-slope converter.
2. Because the integrating capacitor is always charged in a continuous pattern and in the same direction, the dielectric absorption induced error will be relatively small, constant, and will appear as an offset term. This offset term will be removed during the microprocessor's calibration cycle. This feature is unique to this converter and is the key to high linearity.
3. The comparator always sees the ramp voltage approaching the trip point from the same direction and at the same slow rate, regardless of operating conditions. This helps maintain repeatability at the trip point in the face of noise and gain-bandwidth limitations in the comparator.
3. Unlike a dual-slope, this converter has no inherent noise rejection capability. The EX input signal is directly coupled to the comparator input with no filtering. This is a decided disadvantage because most "real world" signals require some smoothing. If a filter was placed at the input substantial time lag due to settling requirements would occur. This is unacceptable because the converter relies on short time intervals between multiplexer states to effectively cancel drift. The solution is to use the microprocessor to filter the signal digitally, using averaging techniques.

Filling Out the Blocks

The detailed schematic diagram of the prototype 20-bit linear A/D converter is shown in *Figure 2*. For clarity, the details of the INS8070 microprocessor and its associated logic are shown in block form. Note that the entire analog section of the converter is fully floating from the digital section to eliminate noise due to digital current spiking and clock noise. The analog and digital circuits communicate via opto-isolators. The full-scale reference for the converter is provided by the LM199A-20-LM108A combination. This circuit, using the components specified, will typically deliver 0.25 ppm/°C performance with drift of several ppm per year. The accuracy to which this reference can be maintained is the primary limitation on absolute accuracy in this converter. The output of this reference is fed to an FET-switched multiplexer which also receives the EX and zero signals. Because all these sources are at low impedance, and only one is switched on at a time, the leakage and ON resistances do not contribute significant error. The A4 combination provides a low bias current unity gain follower with greater than 1,000,00:1 (120 dB) of CMRR, preserving converter linearity. Drifts in this follower are not significant because they will be cancelled out by the microprocessor's calibration cycle. The microprocessor's digital commands to the FET switches are received by the 4N28 opto-isolators. The LM148 quad op-amp (A5) is used to generate the voltage swing necessary to control the FET switches. The discrete components at each amplifier output are used to generate one-way time delays to give the FET switches break-before-make action. This prevents cross talk between the zero, full-scale reference and EX sources.



Notes

- All $\text{J-T} = 2\text{N}4393$
- $\pm 15\text{V}$ for analog circuitry is fully floating
- * Vishay S-102 precision resistor
- * Metal film resistor—RN60C
- † Teflon—Component Research Corp.
- = 1N4148

FIGURE 2

TL/H/5625-2

Another FET is used to reset the integrator and is biased by a "brute-force" level shifting-edge speed-up network formed by the 2N2222-2N2369 pair. A 4N28 optoisolator biases this network when it receives the reset signal from the INS8070 processor. A1, an LF356, has its "+" input biased at about negative 1V, ensuring that the ramp will start far enough below ground to determine a true zero signal.

The requirement for a comparator with 1 ppm (1 LSB at 20 bits = 1 ppm) of trip point noise cannot be met by any standard device. At 10V full-scale this is only a $10\ \mu\text{V}$ LSB. The 50 ms-10V ramp's relatively slow slew rate means that the gain-bandwidth and noise characteristics of a standard differential input comparator will cause considerable uncertainty at the trip point. Also, as the common-mode voltage at which the ramp vs EX crossing occurs changes, the trip point of the comparator will shift, introducing overall non-linearity.

These problems are addressed by the A2-A3 configuration, which forms a high precision comparator. A4's negative output is resistively summed with the positive output of the A1 ramp at A2. A2 normally operates at a low gain due to the diode bounding in its feedback loop. When the currents produced by the ramp potential and A4's output very nearly balance the potential at A2's summing junction will go low enough so that A2 comes out of bound and operates at a gain determined by the 499k feedback resistor (about 100). A2 remains in this high-gain state as long as the ramp and A4 output caused currents are nearly equal. As the ramp continues in its positive going direction the current into A2's summing junction will go to zero and then move positive until the A2 output bounds negative. The output of A2 drives A3, an LM311 comparator which is set up as a zero crossing detector. The components in the positive feedback path at A3 insure a sharp transition. *Figure 3* shows the waveforms of operation. The ramp (a) is shown in highly expanded form. The A2 output (b) can be seen to come cleanly out of diode-bound just before the ramp balances A4's output and then return to bound after the crossing occurs. Waveform (c) is A3's output. The A2 pre-amplifier makes the A3 comparator's job much easier in a number of ways. It amplifies the voltage difference of the two signals to be compared by a factor of 100. This knocks down the effect of A3's input uncertainties. It also produces an apparent 100 fold increase in the ramp slew rate at the trip point. This means A3 spends that much less time with its inputs nearly balanced in an uncertain and noise sensitive condition. Finally, A2 presents the difference signal as a single ended zero crossing signal. This eliminates errors due to changing common-mode voltages that a differential comparator's input would face. Such errors would manifest themselves as overall converter non-linearity.

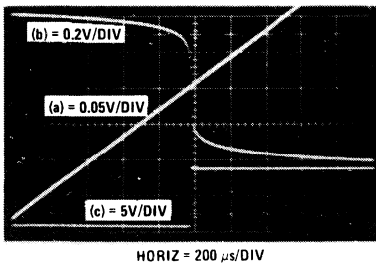


FIGURE 3

The output of the A3 comparator feeds a 2N2369 transistor, which functions as a level shifter-gate. This transistor gates out that portion of the width output pulse which would be due to the length of the integrator reset pulse. The 2N2369, a low storage capacitance device, provides high speed, even in the relatively slow common emitter configuration. The HP-2602 high speed opto-coupler transmits the width information to the digital circuitry.

Converter Performance and Testing

Figure 4 shows the convert at work. A complete conversion cycle is captured in the photograph. Waveform (a) is the integrator reset out of the INS8070. Waveform (b) is the ramp at A1's output. Waveform (c) is the multiplexer output at A4, showing the zero, full-scale reference and EX states. For each state ample time is allowed before the ramp begins. The width output is shown in waveform (d).

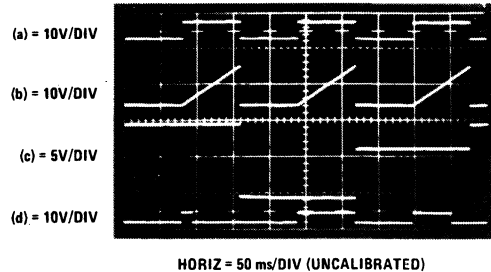


FIGURE 4

TL/H/5625-4

The converter was tested with the arrangement shown in *Figure 5*. The Kelvin-Varley voltage divider, a primary standard type, has a guaranteed linearity of within 1 ppm. The LM11 op amp provides a low bias current, low drift follower to unload the Kelvin divider's output impedance. Because the LM11 gives greater than 120 dB common-mode rejection, its voltage output should track the linearity of the Kelvin divider. To test this the LM11 was adjusted for offset null and a battery-powered μV meter connected between its inputs. 20-bit linear (1 ppm) transfer characteristics were verified by running the Kelvin divider through its range and noting less than $10 \mu\text{V}$ (1 LSB at 10V full-scale) shift under all conditions. Then, the converter reference was used to drive the Kelvin divider input and the LM11 output to the EX input of the A/D converter.

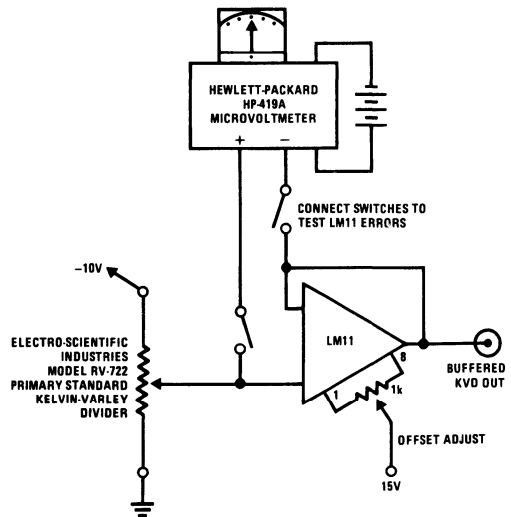


FIGURE 5

TL/H/5625-5

A typical output on the Hewlett-Packard 2644A CRT terminal display is shown in *Figure 6*. For each convert command to the INS8070 the number of counts of zero, full-scale reference and EX are shown along with the final computed answer. Note that the final count is computed to one part in ten million and the last digit is insignificant. Note also that the 4 final counts are all within ± 1 ppm . . . despite the fact that they were individually spaced almost 1 hour apart in a varying thermal environment. Linearity of the converter over a 10V range was verified at 10 points by varying the MSB of the Kelvin divider. Although the prototype converter takes 300 ms to complete a cycle, faster speed is attainable by increasing the 20 MHz clock rate. Perhaps more practically, higher conversion speeds at lower resolutions are easily attainable by simply shortening the ramp time. The converter output word length and conversion time may be varied over a wide dynamic range by juggling clock speed and ramp time.

```

-47- 00/1- 114351
VI COUNT - 002370
FS COUNT - 007701
MICROVOLTS - 0001187

CONVERT
ZERO COUNT - 112870
VI COUNT - 002377
FS COUNT - 007701
MICROVOLTS - 0001188

CONVERT
ZERO COUNT - 112870
VI COUNT - 002377
FS COUNT - 007701
MICROVOLTS - 0001188

CONVERT
ZERO COUNT - 112870
VI COUNT - 002370
FS COUNT - 007703
MICROVOLTS - 0001188
  
```

TL/H/5625-6

FIGURE 6

Although demonstrating a 20-bit converter is useful, there are other applications which do not require this degree of precision. The basic technique is readily adaptable to the practical solution of common transducer and other low-level interface problems. *Figure 7* shows the block diagram of the converter used to generate a 15-bit output directly from a 30 mV full-scale input. In this application the converter input is a differential input amplifier with a nominal gain of 300. Note that the amplifier's offset and gain drift will be cancelled by the microprocessor's calibration loop. The EX signal is the output of the transducer bridge. The full-scale reference signal is derived by measuring across the middle resistor of a string which has the same voltage across it as the nominal

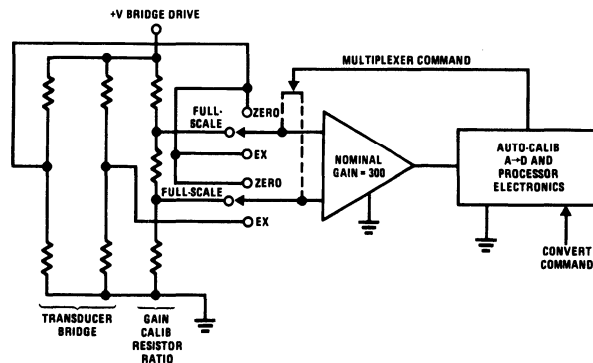


FIGURE 7

TL/H/5625-7

bridge output for a given bridge drive level. In this manner, even if the bridge drive varies, the gain of the system remains calibrated by ratiometric error cancellation. The zero signal is derived by shorting both amplifier inputs to the common-mode voltage at the bridge output. This system has been built and has maintained 15-bit accuracy over a 75°F temperature range.

Prospective constructors of this converter are advised that construction technique is extremely critical. In order for the converter to operate properly, the greatest care must be taken in grounding, guarding and shielding techniques. Useful sources of information are listed in the References

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About Integrating Converters and Capacitors

The simplest form of integrating converter is the single-slope type (*Figure A*). In the single-slope unit shown, a linear reference ramp is compared against the unknown input, EX. When the switch across the integrator capacitor is opened, the ramp begins. The time interval between the opening of the integrator reset switch and the comparator changing state (when $E_{RAMP} = EX$) is directly proportional to the value of EX. This converter requires that the integrating capacitor and the clock used to measure the time interval be stable over time and temperature ... a significant drawback under normal circumstances.

The dual-slope integrator (*Figure B*) overcomes these problems by effectively normalizing the capacitor value and clock rate each time a conversion is made. It does this by integrating the EX input for a pre-determined time. Then, the voltage reference is switched to the integrator input which proceeds to integrate in a negative going direction from the EX slope. The length of time the reference slope requires to get back to zero is proportionate to the EX signal value. These slopes are both established with the same integrating capacitor and measured with the same clock, so both parameters need only be stable over one conversion cycle.

Both of these converters are dependent to varying degrees on capacitor characteristics. The single-slope type requires stability in the capacitor over time and temperature while the dual-slope gets around this limitation. The effects of a phenomenon in capacitors called dielectric absorption, however, have direct impact on dual-slope performance. Dielectric absorption is due to the capacitor dielectric's unwillingness to accept or give up charge instantaneously. It is commonly and simply modeled as a parasitic series RC (*Figure C*) across the terminals of the main capacitor.

If a charged capacitor is discharged, even through a dead short, some degree of time will be required to remove all of the charge in the parasitic capacitance due to the parasitic series resistance. Conversely, some amount of charge will be absorbed by the parasitic capacitor after a charging of the main capacitor has ceased unless the charge source is maintained for many parasitic RC time constants. Various dielectrics offer differing performance with respect to dielectric absorption. Teflon, polystyrene and polypropylene are quite good, while paper, mylar and glass are relatively poor. Electrolytics are by far the worst offenders. Anyone who has received a shock after discharging a high voltage electrolytic in a television set has experienced the effect of dielectric absorption.

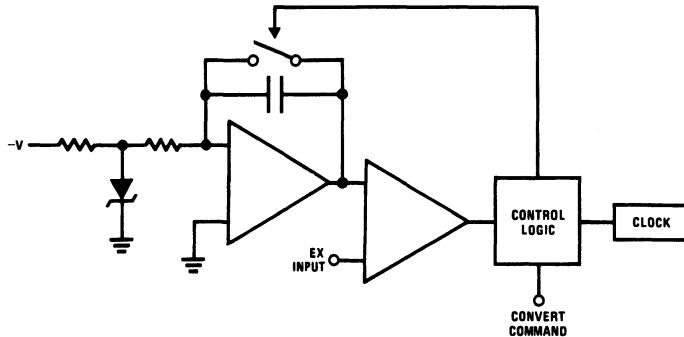


FIGURE A

TL/H/5625-9

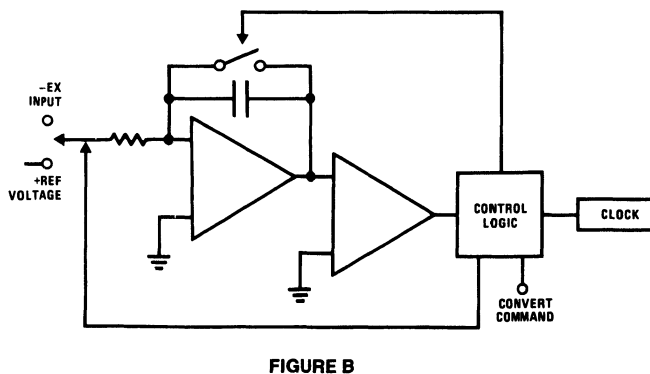


FIGURE B

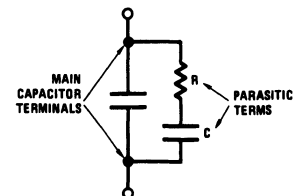


FIGURE C

TL/H/5625-8

Low Distortion Wideband Power Op Amp

National Semiconductor
Application Note 261



AN-261

The LH0101 is a new power operational amplifier capable of delivering a high-current low-distortion output. The device is conservatively rated at 2 amps continuous current. A novel design technique is used to eliminate the crossover distortion often plaguing power op amps. Additional features include a frequency response from DC to greater than 4 MHz. Excellent DC performance is attained by using FET input devices, and the unity gain frequency compensation has been performed internally. Finally, the device is hermetically sealed in a standard 8-pin TO-3 power package.

The initial LH0101 design goal was to develop an easy to use wideband operational amplifier capable of driving a variety of loads. This requirement focused a major portion of the design effort in the power output stage where considerable emphasis was placed on eliminating crossover distortion. Another consideration was to remove the ground connection typically associated with power amplifiers in order to ease the usage with single or dual power supply configurations.

Our discussion is sectioned into three subtopics where the first details the LH0101 internal circuitry, the second presents a variety of user product development/design precautions, and the third presents typical applications for the LH0101, supported by circuit diagrams.

TABLE I. LH0101 Typical Performance Characteristics at 25°C Ambient, ±15V Supply

Parameter	Conditions	Value
Output Current		2A
Input Offset Voltage		5 mV
Input Bias Current		50 pA
Input Offset Current		25 pA
Input Resistance		$10^{12}\Omega$
Large Signal Voltage Gain		200V/mV
Output Voltage Swing	$R_L = 100\Omega$	$\pm 12.5V$
	$R_L = 10\Omega$	$\pm 11.6V$
	$R_L = 5\Omega$	$\pm 11V$
Slew Rate	$A_V = +1$	10/ $V\mu s$
Full Power Bandwidth	$A_V = +1, R_L = 10\Omega$	300 kHz
Small Signal Rise Time	$A_V = +1, R_L = 10\Omega$	10 ns
Small Signal Settling Time to 0.01%	$V_{IN} = 10V, A_V = +1$	2 μs
Gain Bandwidth		4 MHz
Harmonic Distortion	$f = 1 \text{ kHz}, P_O = 1W$	0.005%
	$R_L = 10\Omega, A_V = +1$	
	$f = 20 \text{ kHz}, P_O = 1W$	0.05%
	$R_L = 10\Omega, A_V = +1$	

CIRCUIT TOPOLOGY

The LH0101 consists of 3 essential stages, an operational amplifier, a buffer, and a power output stage.

Selection of a BI-FET operational amplifier was prompted by a balance between the desired AC and DC performance. This decision was made in order to take advantage of the high performance BI-FET series' slew rate, settling time, and low bias current characteristics. The added feature of internal frequency compensation aided in making it an ideal amplifier upon which to build.

The zero-crossing distortion associated with high current and high frequency conditions is an age-old problem of class B and class AB power amplifiers. In order to minimize the distortion at crossover, the amplifier must maintain a low output impedance throughout zero crossing. This requires the push-pull output transistors to smoothly alternate current sourcing and sinking duty during the crossover.

To obtain a low output resistance the output stage must constantly remain in the active region. The usual approach is to incorporate a class AB output stage similar to that shown in *Figure 1*. During no load conditions, both output transistors are biased ON thus providing a low output resistance and hence eliminating crossover distortion. Under rated current load conditions, however, a potential source of distortion can develop. Take the case of an output at a positive voltage delivering the rated current to a load. The increased base-to-emitter voltage of the drive transistor tends to bias the bottom transistor OFF.

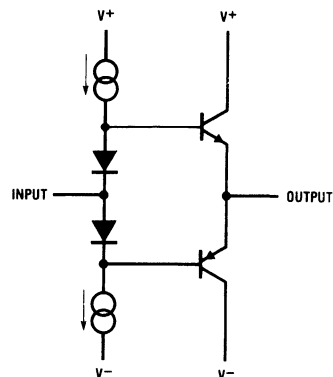


FIGURE 1. Class AB Output Stage as a Possible Solution to Minimize Distortion

TL/H/6865-1

As the output swings negative, crossover distortion can be seen to depend upon how quickly the bottom transistor can turn ON to assume its drive portion of the duty cycle. This condition becomes more acute at higher frequencies.

Of even greater concern is the risk of thermal runaway. An internal rise in temperature decreases transistor junction voltages which in turn increase the collector operating current. Typically emitter degeneration resistors can be used to compensate for this effect, but prove themselves inadequate under rated current load conditions. In order to minimize the junction voltage temperature effect a large resistor value must be selected. At the same time this limits the output drive current and, hence, the output voltage swing. On the other hand, if a small resistor value is selected, the output drive current is maintained but the voltage drop across this small resistance is inadequate to compensate for a decrease in junction voltage. This result brings the problem back to one of thermal runaway and clarifies the shortcomings of *Figure 1*.

Another commonly used technique is a pseudo-class B output stage found in many integrated power op amps, (see *Figure 2*). In this configuration, the limited output swing problem of class AB amplifiers is eliminated. The output swings to within one or two volts of either supply.

The obvious problem with this type of circuit is that it has significant crossover distortion. Distortion occurs when both output transistors are biased completely OFF during zero crossing, thus exhibiting relatively high resistance at the amplifier output. In addition, the minor loop feedback between the base drive of the transistors and the output almost always induces an abrupt change in the response. This further aggravates the amplifier distortion.

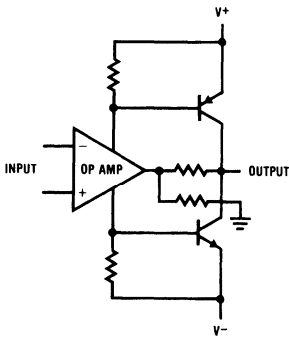


FIGURE 2. Class B Output Stage

TL/H/6865-2

The new op amp successfully combines both techniques to achieve remarkably smooth crossover transitions under most demanding conditions. The complete schematic is shown in *Figure 3*.

The buffer stage, which consists of transistors Q3, Q5, Q10, and Q11 is a current amplifier with unity voltage gain. Connected as a class AB amplifier, its function is to provide distortion-free drive during zero crossing. Bandwidth is in excess of 50 MHz to ensure no bandwidth-induced distortion.

The buffer stage output is current limited by transistors Q7 and Q8 to no more than 50 mA. However, the power stage transistors Q1 and Q2 are designed to turn ON as the load current reaches about 25 mA. Any additional current demanded is sustained by these two output transistors right up to the rated output limit. Thus, the reserve drive of the buffer stage is used only to "smooth" the turn-on delay of the output Darlington transistors.

Q6 and Q9 base-to-emitter junctions are used as current limit sense to protect the output stage. Current sense resistors connected between the supply pins and the SC pins program the limit threshold. In operation, an approximate 0.6V differential turns ON either transistor Q6 or Q9, which in turn drives Q12 and Q4 respectively, starving any excess base current from driving the output beyond the preset limit.

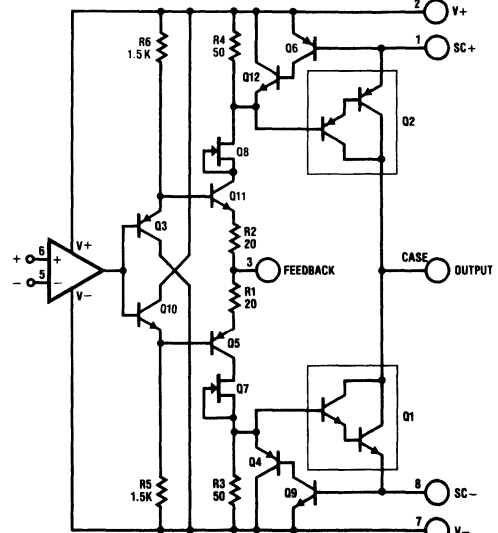
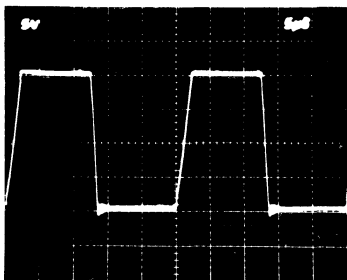


FIGURE 3. LH0101 Complete Schematic

TL/H/6865-3

RESULT

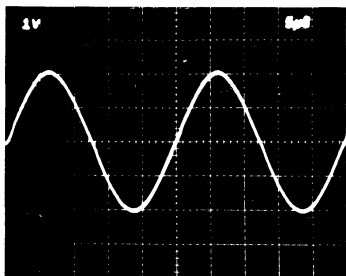
The performance of the LH0101 is best demonstrated in the following photographs. *Figure 4* shows the large signal slew response of the LH0101 into a 10Ω load. No crossover distortion is evident.



TL/H/6865-4

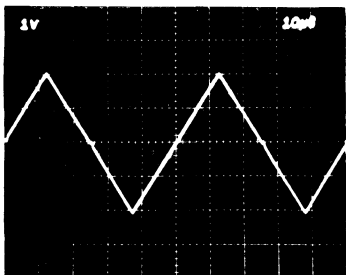
FIGURE 4. Large Signal Pulse Response, 10Ω Load

Generally, crossover distortion occurs within a small region near zero crossing. In order to amplify its effect, a signal of small amplitude is used. *Figures 5* and *6* show a signal amplitude of 2 volts peak, and loads of 10Ω and 1Ω respectively. Notice that a slight distortion is observed in *Figure 6*, but only under the extreme condition imposed by the 1Ω load!



TL/H/6865-5

FIGURE 5. Small Signal Response, 10Ω Load



TL/H/6865-6

FIGURE 6. Small Signal Triangular Wave Response, 1Ω Load

DESIGN PRECAUTIONS

Circuit Layout Considerations

In high power applications, one must pay close attention to the trace connections in which high current is carried. Critical connections should be short to minimize line drop. For example, a $10\text{ m}\Omega$ PC trace carrying 2 amps develops 20 mV of error voltage. It is important to be aware of where this error is generated and how it impacts accuracy.

Ground connections are probably the most important, if not the most troublesome. Not only can they contribute to circuit error, but in many situations the circuit can become unstable if the layout induces excessive phase error. *Figure 7* shows one correct technique for circuit grounding. The heavy lines represent high current paths. The analog signal ground is returned to the supply common.

Output Current Limit

As described in the previous section, current sense resistors may be inserted between the supply pins and the SC pins to limit excessive load currents. A voltage of 0.6V developed across the sense resistor triggers the limiting circuit. *Figure 8* illustrates the usage.

In cases where the chosen R_{SC} is small ($< 1\Omega$), the contact resistances from solder connections and socket ohmic contacts become important and must not be overlooked. A good solder joint typically exhibits 5 m Ω of resistance and socket contacts have about 10 m Ω . Even interconnecting traces will become significant if they are long.

Consider the circuit in *Figure 8*; a pair of good solder joints on the 0.3Ω current sense resistors contribute more than 3% error. Also, one can expect the current sense transistor threshold to vary as much as 10% from device to device. Furthermore, this threshold has a temperature coefficient of $-2\text{ mV}/^\circ\text{C}$. In summary, the expected accuracy is on the order of 20% to 25% under all operating conditions.

When designing the current limit, the threshold should not be set too close to the worst case peak current under any normal operating conditions. Signal distortion will occur even if the threshold is intermittently exceeded for a very short duration. In the worst instance, the circuit can trigger spurious oscillation, such as in the case of driving a capacitive load during transient conditions. These occurrences are very real in nearly all op amps having similar current sense circuits. Although the current limit circuit has high enough gain to produce a sharp response, it is a good idea to allow a 20% margin above the worst case operating condition.

Safe Operating Conditions

In order to preserve the reliable performance of the LH0101, the device must not operate beyond the boundary defined in the Safe Operating Area curve in the data sheet. Because of its importance, it has been reproduced in *Figure 9*.

Power Dissipation Considerations

Probably the single most important gauge of reliability is the operating temperature of this device. The derating curve, which has again been reproduced in *Figure 10*, must be followed faithfully. Similar to the Safe Operating Area curve, under no circumstances should the boundary be exceeded. The curves relate operating and junction temperature, power dissipation and thermal resistance. The general relationship is expressed as follows.

$$P_{DISS} = \frac{T_{J(MAX)} - T_{A(MAX)}}{R_{\theta JC} + R_{\theta CS} + R_{\theta SA}} \quad (1)$$

- where: P_{DISS} = the power dissipated by the device in watts.
- $T_{J(MAX)}$ = the maximum junction temperature allowed, for the LH0101, $T_{J(MAX)} = 150^{\circ}\text{C}$.
- $T_{A(MAX)}$ = the maximum ambient temperature in $^{\circ}\text{C}$ under which the device must operate.
- $R_{\theta JC}$ = thermal resistance from the junction to case in $^{\circ}\text{C}/\text{W}$, for the LH0101, $R_{\theta JC} = 2.5^{\circ}\text{C}/\text{W}$.
- $R_{\theta CS}$ = thermal resistance from case to surface of heat sink in $^{\circ}\text{C}/\text{W}$.
- $R_{\theta SA}$ = thermal resistance from heat sink to free air ambient in $^{\circ}\text{C}/\text{W}$.

In simple terms, the expression is a measure of how well the internally generated heat is removed such that the power dissipated will not give rise to a maximum permissible junction

temperature of 150°C . Thus, the sum of all the thermal resistance represents the thermal efficiency of the mechanical design. The lower the sum, the more efficient the thermal conductivity.

In a typical design, first and foremost is to calculate the maximum power dissipation that the device is designed to handle. There are two components, which are related by the following equation:

$$P_{DISS} = P_Q + P_O \quad (2)$$

The first part of the equation is the quiescent power at which the device operates under no load. The second term is the power dissipated by the output transistors due to the load. This is calculated as the average voltage difference between the supply voltage and the output voltage multiplied by the maximum rms load current the amplifier is required to deliver.

Once the power dissipation is calculated, the next step is to determine the maximum ambient temperature in which the device must operate.

To complete the thermal design, all contributions of thermal resistances must be summed per equation (1) above. First, the junction-to-case thermal resistance for the LH0101 is given in the data sheet; it is typically $2.5^{\circ}\text{C}/\text{W}$.

The metal case of the LH0101 is electrically connected to the output of the amplifier. Unless the application permits direct mounting to a heat sink, a sheet of insulation should be sandwiched between the case and the mounting surface for isolation purposes. Many types of insulators are available. The most popular of these is mica film. Its thermal resistance is listed in Table II along with other types.

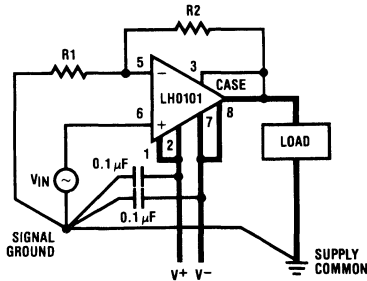


FIGURE 7. Proper Supply Connection

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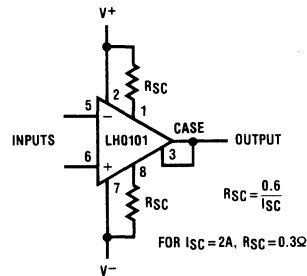


FIGURE 8. Current Limit Protection

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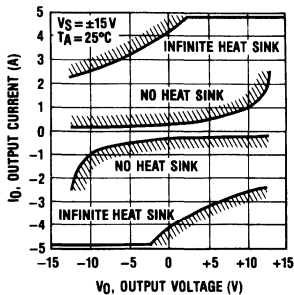


FIGURE 9. Safe Operating Area

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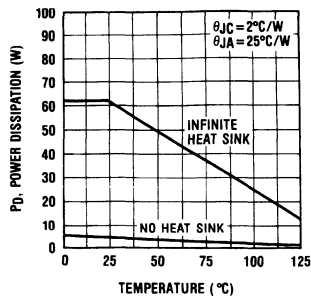


FIGURE 10. Power Derating Curve

TL/H/6865-10

TABLE II. Thermal Resistance (Note 1)

Insulator Material Type	W/O Thermal Joint Compound	W/Thermal Joint Compound	Sources
Mica	1.3°C/W @ 0.003" thick 1.2°C/W @ 0.002" thick	0.25°C/W 0.33°C/W	Thermalloy Inc. Keystone Electronics Mod. # 4658
Thermalfilm ¹²	1.5°C/W @ 0.002" thick	0.52°C/W	Thermalloy Inc.
Aluminum Oxide ²	1.0°C/W @ 0.062" thick	0.3°C/W	
Beryllium Oxide ²⁻³	0.6°C/W @ 0.062" thick	0.15°C/W	
Insul-Cote ²	0.5°C/W @ 0.002" thick		Thermalloy Inc.

Note 1: Mounting bolts torqued to 6 oz.-in.

Note 2: Consult manufacturer on availability for 8-lead TO-3 package style.

Note 3: Particle, dust, or fumes present health hazards when inhaled. Grinding, sanding, and pulverizing the material should be avoided.

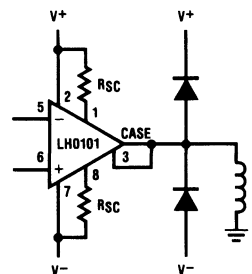
In critical applications, thermal-joint compound should be used to maximize heat transfer across the heat sink. With air being a poor heat conduction medium, the use of thermal joint compound eliminates air gaps between mounting surfaces, thus providing more than 3 times improvement in thermal efficiency over those cases without.

The remaining unknown, $R_{\theta SA}$, can now be determined from the proper selection of the heat sink. By itself, that is, with no heat sink, the TO-3 case has a junction-to-ambient thermal resistance ($R_{\theta JA}$ or θ_{JA}) of about 25°C/W. Consequently, a heat sink is almost always required in applications involving significant power. Most heat sink manufacturers specify the mounting-surface to ambient thermal resistance $R_{\theta SA}$. In a nutshell, the heat sink is selected such that the right hand side of equation (1) is equal to or greater than the left hand side, or total power dissipation. It is good engineering practice to allow at least a 10% safety margin.

Design Consideration Driving Inductive Load

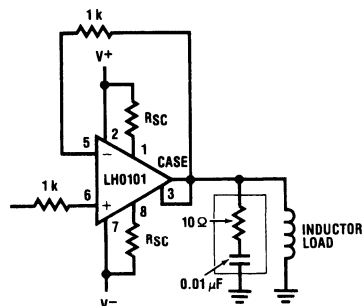
The LH0101 is suitable for driving most inductive loads including voice-coils and motors. However, in many situations the device should be protected from the harmful effects of energy stored in the inductor. Such a condition exists when power is removed from the circuit at an instant when a high current is flowing through the inductor. A back-emf may have energy high enough to forward bias internal junctions at a current density level sufficient to destroy the device. Figure 11 illustrates a simple way to prevent this.

Theoretically, an inductive load does not cause amplifier loop instability. However, if the circuit Q is high enough and stray capacitances are within a critical range, the load circuit can break out into oscillation. A series RC damping circuit of 10Ω and a 0.01 μF capacitor across the inductor as shown in Figure 12 usually alleviates the problem.



TL/H/6865-11

FIGURE 11. Back EMF Suppression Technique



TL/H/6865-12

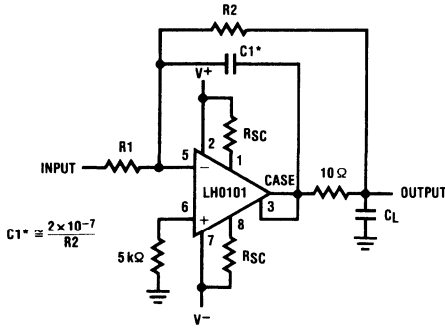
FIGURE 12. RC Damping to Compensate Inductor Load

In some applications where it is desirable to prevent power surges from actuating the load, for example a motor valve actuator or a disk drive read/write head servo loop, the same RC damping circuit provides an alternate conductive path to suppress surge current.

Design Considerations Driving Capacitor Load

Capacitive loads tend to create an unwanted pole at the tail end of the frequency response where the open loop gain approaches unity gain frequency. The effect is a net reduction of phase margin. For example, a 500 pF load capacitor reduces the phase margin of the amplifier from a no load of 58° to 45°. A 1000 pF capacitor pushes it down to 40°. With a large 0.01 μF capacitor, the amplifier has a mere 22° phase margin. The latter cases are susceptible to oscillation. Figure 13 shows a compensation technique to restore stability. The value of the lead capacitor C1 should be such that the capacitive reactance is one-fifth the resistance of R2 at the unity-gain crossover frequency of the amplifier, or 4 MHz.

It is interesting to note that there is a critical value for the load capacitor above which oscillation cannot occur. That value is approximately 0.1 μF. Under such a condition, the time constant is so large that the heavy damping effectively suppresses any chance for the circuit to oscillate.



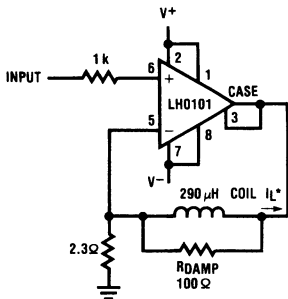
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FIGURE 13. Compensation for Capacitance Load

TYPICAL APPLICATIONS

CRT Yoke Driver

One of the most natural applications for the LH0101 op amp is the deflection yoke driver for high resolution CRTs. The low distortion characteristics allow virtually unrestricted use in any circuit configuration. A typical design is shown in Figure 14.



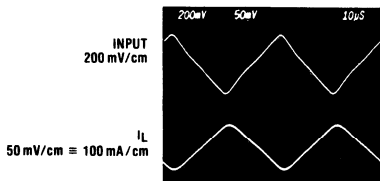
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*Coil Current I_L Measured with

Tektronix Current Probe Model P6042.

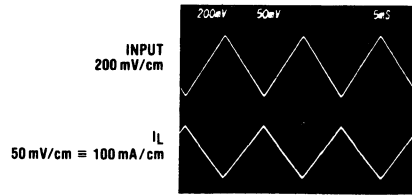
FIGURE 14. CRT Yoke Driver Circuit

A 500 mV peak-to-peak triangular waveform about ground is input to the amplifier, giving rise to a 100 mA peak current to the inductor. As shown in Figures 15 and 16, the responses were recorded at 60 Hz and 20 kHz respectively. At higher frequencies, R_{DAMP} becomes important. The value should be selected to yield the cleanest waveform.



TL/H/6865-15

FIGURE 15. 60 Hz Current Drive Waveform of CRT Deflection Coil



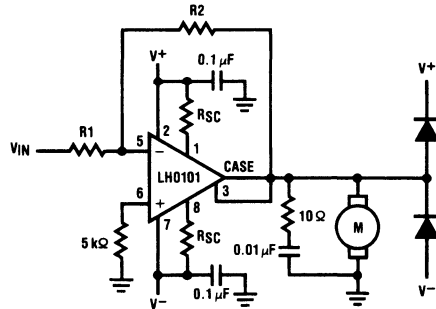
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FIGURE 16. 20 kHz Current Drive Waveform of CRT Deflection Coil

Servo Motor Amplifier

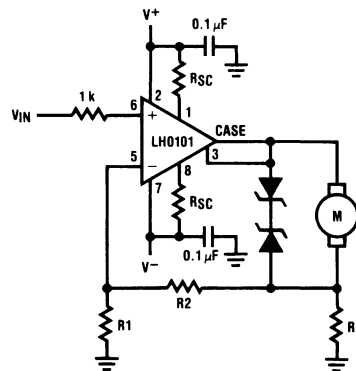
A typical motor driver circuit is shown in Figure 17. The amplifier will deliver the rated current into the motor. Again, care should be taken to keep power dissipation within the permitted level.

A variation of the same servo design is shown in Figure 18. This precision speed regulation circuit employs rate feedback for constant motor current at a given input voltage.



TL/H/6865-17

FIGURE 17. Servo Motor Amplifier



TL/H/6865-18

FIGURE 18. Rate Feedback Servo Motor Amplifier

Digitally Programmable Power Source

Designing precision voltage and current sources is made simple using the LH0101. Adding a digital-to-analog converter provides a tremendous amount of flexibility in speed and control. Applications range from DC precision power supplies to sophisticated programmable waveform generators. The design of the voltage source is relatively straightforward, whereas the programmable current source is a bit more involved. Such a circuit is shown in *Figure 19*. The DAC is configured to operate in a bipolar mode with an output range of $\pm 10.000\text{V}$. With 12 bits, the DAC outputs an equivalent of 4.88 mV per bit-weight. Consequently, the resolution at the current source is $0.488 \mu\text{A/bit}$.

The output sources and sinks current only to ground referenced loads. A negative full-scale code (all digital inputs low) effects a negative (source) 1 amp current output. A zero scale (MSB low and all other bits high) gives zero current. And a positive full scale code (all digital inputs high) forces a positive (sink) 1 amp current at the output.

The versatility of this circuit configuration is not without limitation. Because the output voltage is dependent upon the ground referred load, one must be aware of the potentially destructive power dissipation level the LH0101 must sustain. For example, 1A current into a 5Ω grounded load generates 10W of power in the amplifier. This level is high enough to destroy the device unless an appropriate heat sink is used to keep the device junction temperature from exceeding the 150°C limit.

Coaxial Cable Driver

The LH0101 makes an ideal cable driver of any type. It has adequate bandwidth for most audio and sub-video applications. The high current, distortion free output can easily interface any termination required. Large line capacitance does not present a problem for the LH0101. It has adequate reserve current capability to charge the capacitance without seriously degrading bandwidth. However, current limit protection against cable shorts is recommended. A typical interface circuit is shown in *Figure 20*. The op amp can drive up to 6 coaxial lines without the use of a heat sink.

Low Distortion Audio Amplifier

At this juncture, it would be of great interest to see how well the LH0101 performs in the audio high fidelity arena. The intent here is not to set a new standard but merely to use the stringent requirements of the audio specifications as an ideal yardstick for comparison.

The complete design is illustrated in *Figure 21*. The circuit is configured as a bridge amplifier to maximize available output power for a given set of supply voltages.

The result is an impressive set of specifications summarized in Table III. Although not earth-shaking, 0.14% total harmonic distortion at the rated 40W output, within the full audio frequency spectrum, is very respectable.

Transient slew rate of greater than $10\text{V}/\mu\text{s}$ extends the full power bandwidth to beyond 200 kHz, and the distortion response is plotted over the entire audio spectrum in *Figure 22*. This would satisfy all but a handful of audio purists.

About the only difficulty encountered was finding a heat sink that was good enough for convection cooling. By following the previous section on Power Dissipation Considerations, the heat sink thermal resistance required is a maximum of 3.5°C/W at an ambient temperature of 25°C . The calculation included the use of mica insulator and liberal use of thermal-coat compound. As it turned out, a large extruded heat sink with fins similar to the Thermalloy type 6141 did an excellent job of keeping the junctions cool.

TABLE III. Bridge Audio Amplifier Specifications

A_V (Voltage Gain)	3
Z_{IN} (Input Impedance)	10 k Ω
I_Q (Quiescent Current)	60 mA
P_O (Output Power)	40 Watts into 8Ω
—RMS Continuous 20 Hz–20 kHz	28 Watts into 16Ω
Full Power Bandwidth	DC to > 100 kHz
THD (Total Harmonic Distortion)	
1W 20–20,000 Hz	<0.8%
40W 20–20,000 Hz	<0.15%
IMD (Intermodulation Distortion)	
1W 60 Hz/100 kHz 4:1	<0.01%
40W 60 Hz/100 kHz 4:1	<0.002%
Peak Output Current	3.125A into 8Ω
Supply Voltage	$\pm 18\text{V}$
Maximum Output Voltage Swing	21.2V rms 30V Peak

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1. National Semiconductor, *Special Functions Databook*.
2. National Semiconductor, *Linear Applications Handbook*.
3. J. Wong, J. Sherwin, "Applications of Wide-Band Buffer Amplifier", National Semiconductor AN-227, October 1979.
4. National Semiconductor "LH0101 Power Operational Amplifier" data sheet.

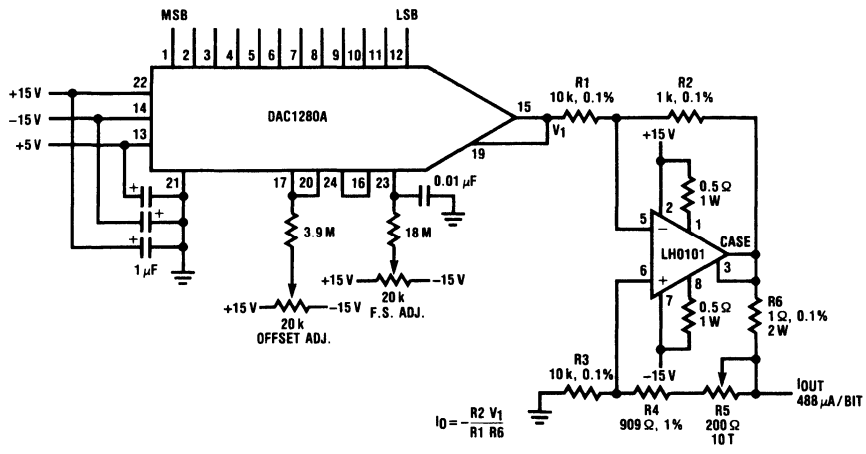


FIGURE 19. Digitally Programmable Current Source

TL/H/6865-19

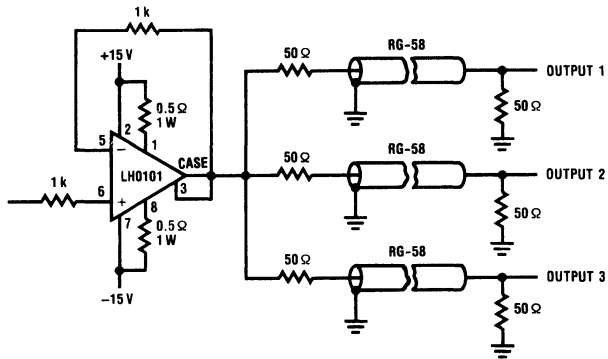
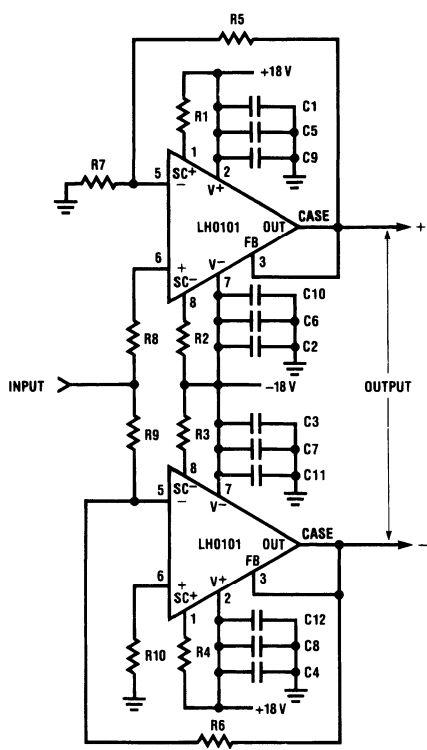


FIGURE 20. Multi-Line Coaxial Cable Driver

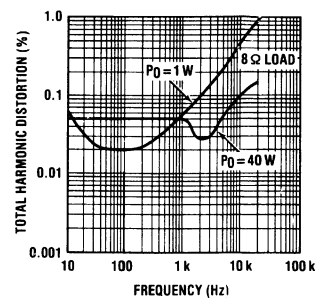
TL/H/6865-20



TL/H/6865-21

R1-R4	Current Limit Resistor	0.15Ω, 2W
R5	Feedback Resistor	5 kΩ
R6	Feedback Resistor	15 kΩ
R7-R10	Input Resistors	10 kΩ
C1-C4	Bypass Capacitors	47 μF, 25V Electrolytic
C5-C8	Bypass Capacitors	10 μF, 25V Tantalum
C9-C12	Bypass Capacitors	0.1 μF, 25V Ceramic

FIGURE 21. LH0101 Bridge Audio Power Amplifier



TL/H/6865-22

FIGURE 22. Total Harmonic Distortion vs Frequency of Bridge Power Amplifier

Applying Dual and Quad FET Op Amps

National Semiconductor
Application Note 262



The availability of dual and quad packaged FET op amps offers the designer all the traditional capabilities of FET op amps, including low bias current and speed, and some additional advantages. The cost-per-amplifier is lower because of reduced package costs. This means that more amplifiers are available to implement a function at a given cost, making design easier. At the same time, the availability of more amplifiers-per-dollar means that relatively self contained and sophisticated functions can be designed around a single FET dual or quad package. In addition, duals and quads require less board space, fewer bypass capacitors and less power supply bussing. An inventive designer can capitalize on all of these advantages to produce complex circuit functions at low cost. An example is shown in *Figure 1*.

HIGH EFFICIENCY PRECISION OVEN TEMPERATURE CONTROLLER

In this circuit, a complete, high efficiency pulse width modulating temperature controller is built around a single LF347 package. In *Figure 1*, A1 functions as an oscillator whose output (Trace A, *Figure 2*) periodically resets the A2 integrator output (Trace B, *Figure 2*) back to zero volts. Each time A1's output goes high, a large positive current is forced into A2's summing junction, overcoming the negative current that flows through the 100 k Ω resistor into the LM129 reference. This forces A2's output to head in a negative-going

direction ultimately limited by the diode feedback-bound. Another diode provides bias at A2's "+" input to compensate the bound diode and A2's output settles very near zero volts. When the positive output pulse from A1 ends, the positive current into A2's summing junction ceases and A2's output ramps linearly until the next reset pulse.

A3 functions as a current summing servo-amplifier which compares the currents derived from the LM135 temperature sensor and the LM129 reference. In this example A3 operates at a gain of 1000 with a 1 μ F capacitor providing 0.1 Hz servo response. A3's output represents the amplified difference between the LM135's temperature and the desired control setpoint, which may be varied by altering the 21.6k value. In this circuit the 21.6k resistor provides a setpoint of 49°C. A3's output is compared to the ramp output of A2 and A4, which is set up as a comparator. A4's output will only be high during the time A3's output is greater than the ramp voltage. The ramp reset pulse is diode-summed with the ramp output (Trace C, *Figure 2*) at A4 to prevent A4's output from going high during the period of the reset pulse. A4's output biases the LM395 power transistor which switches power to the heater (Trace D, *Figure 2*). If the LM135 sensor is tightly coupled to the heater and the oven is well insulated, this controller will easily hold 0.05°C over wide excursions of ambient temperature.

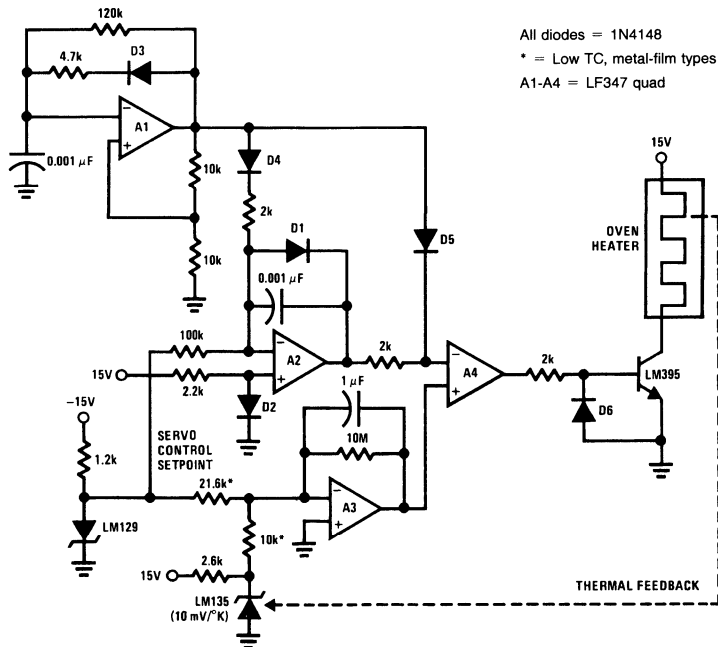
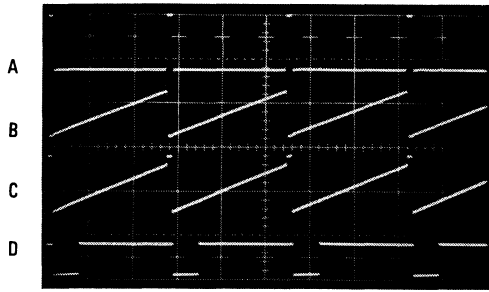


FIGURE 1. Connecting appropriate components to an LF347 quad FET op amp IC produces a high efficiency precision oven temperature controller. This design can hold a temperature within 0.05°C despite wide ambient temperature fluctuations.

TL/H/6932-1



TL/H/6932-2

Trace	Vertical	Horizontal
A	20V/Div	50 μ s/Div
B	10V/Div	
C	10V/Div	
D	20V/Div	

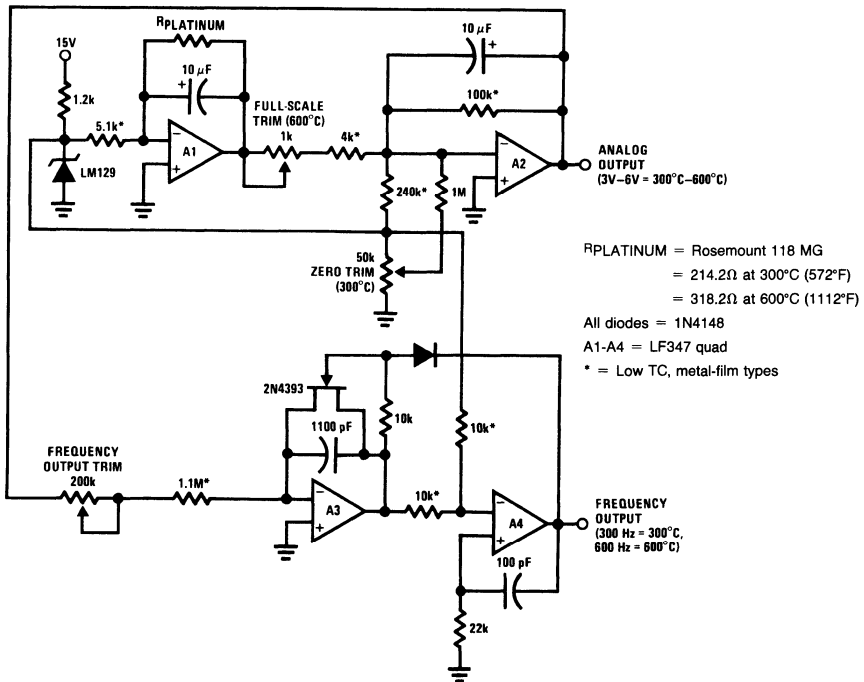
FIGURE 2. Oven-controller waveforms from *Figure 1's* circuit show A1's oscillator output (Trace A) and A2's integrator output (B) as the latter resets periodically to 0V. Trace C displays A4's ramp input, and (D) indicates the LM395's power input to the oven heater.

PLATINUM RTD HIGH TEMPERATURE THERMOMETER WITH ANALOG AND DIGITAL OUTPUTS

Another temperature related circuit appears in *Figure 3*. In this circuit an LF347 is used to signal condition a Platinum RTD and provide simultaneous analog and frequency outputs. These outputs are accurate to $\pm 1^\circ\text{C}$ over a range of 300°C – 600°C (572°F – 1112°F). Although the circuit maintains linearity over a much wider range the non-linear response of the RTD over wide range is the limitation to accurate, wide range operation (see graph, *Figure 4*).

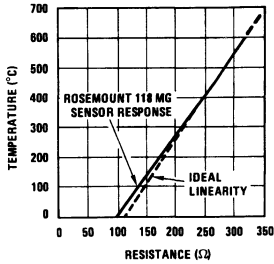
A1 functions as a negative gain inverter to drive a constant current through the platinum sensor. The LM129 and the 5.1k resistor provide the current reference. Because A1 operates at negative gain the voltage across the sensor is extremely low and self-heating induced errors are eliminated. A1's output potential, which varies with the platinum sensor's temperature, is fed to A2. A2 provides scaled gain and offsetting so that its output will swing from 3.00V to 6.00V for a 300°C to 600°C temperature swing at the platinum sensor.

A3 and A4 form a voltage-to-frequency converter which generates a 300 Hz to 600 Hz output from A2's 3V to 6V analog output. A3 integrates in a negative-going direction at a slope which is linearly dependent upon A2's output voltage. A4 compares A3's negative ramp to the LM129's positive reference voltage by current summing in the 10 k Ω resistors. When the negative value of the ramp just exceeds the LM129 voltage A4's output goes positive, turning on the 2N4393 FET and resetting the A3 integrator. AC feedback at A4 causes it to "hang up" in the positive state long enough to completely discharge the integrator capacitor.



TL/H/6932-3

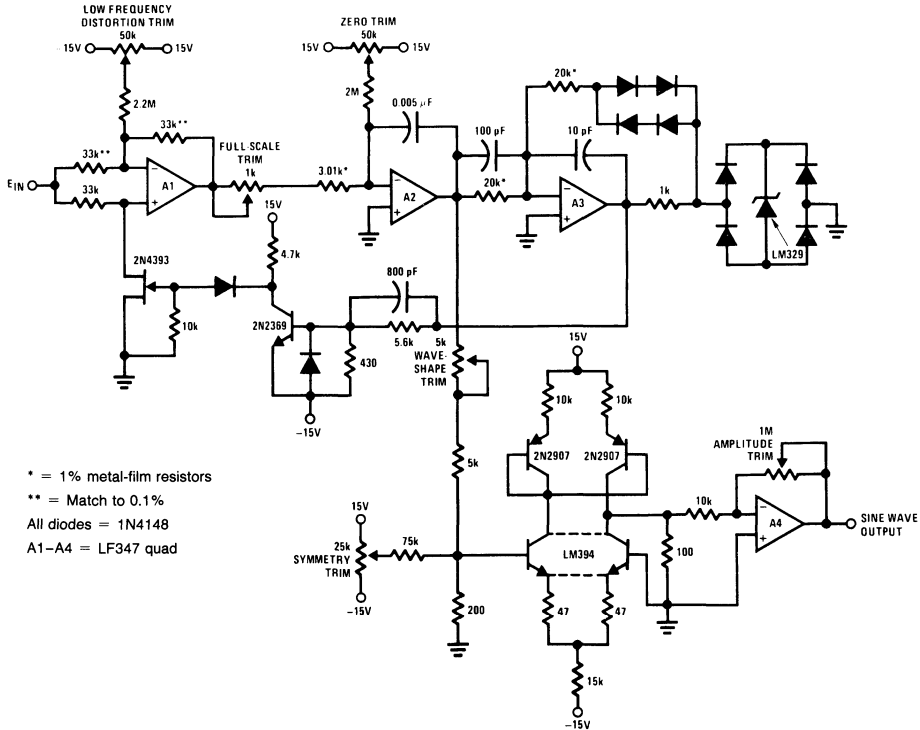
FIGURE 3. Generate simultaneous analog level and frequency outputs using one LF347 package by signal-conditioning a platinum RTD sensor. You can calibrate this high temperature (300°C to 600°C) measuring circuit to $\pm 1^\circ\text{C}$ by using three trimming pots.



TL/H/6932-4

Temperature(°C)	Resistance(Ω)
600	318.2
500	284.7
400	249.8
300	219.2
200	177.3
100	139.2
0	100.0

FIGURE 4. A platinum RTD sensor's resistance decreases linearly from 600°C to 300°C. Then, from 300°C to 0°C, the sensor's resistance deviates from a straight line slope and degrades the Figure 3 circuit's accuracy beyond $\pm 1^\circ\text{C}$.



TL/H/6932-5

FIGURE 5. An LF347-based voltage-controlled sine wave oscillator combines high performance with versatility. For 0V to 10V inputs, this circuit generates 1 Hz to 20 kHz outputs with better than 0.2% linearity and only 0.4% distortion.

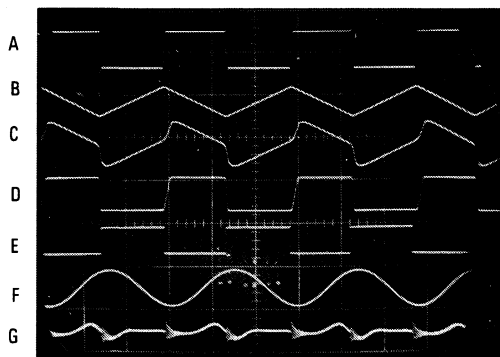
To calibrate this circuit, substitute a high quality decade box (e.g., General Radio #1432-K) for the sensor. Alternately adjust the zero (300°C) and full-scale (600°C) potentiometers for the resistance values noted in Figure 4 until A2's output is calibrated. Next, adjust the 200 k Ω frequency output trim so the frequency output corresponds to the analog value at A2's output.

VOLTAGE CONTROLLED SINE WAVE OSCILLATOR

Figure 5 diagrams a very high performance voltage controlled sine wave oscillator which uses a single LF347 package. For a 0V–10V input the circuit produces sine wave outputs of 1 Hz to 20 kHz with better than 0.2% linearity. In addition, distortion is about 0.4% and the sine wave output frequency and amplitude settle instantaneously to a step input change. The circuit's sine wave output is achieved by non-linearly shaping the triangle wave output of a voltage-to-frequency converter.

Assume the 2N4393 FET is on and A1's output has just gone low. With the FET on, A1's "+" input is grounded and A1 functions as a unity gain inverter. In this state its output will be equal to $-E_{IN}$ (Trace A, Figure 6). This negative voltage is applied to the A2 integrator which responds by ramping in a positive direction (Trace B, Figure 6). This positive-going ramp is compared by A3 to the LM329 7V reference which is contained within its symmetrically bounded positive feedback loop. The paralleled diodes compensate the diodes in the bridge. When the positive-going ramp voltage just nulls out the -7V produced by the LM329, diode

bound A3's output goes positive (Trace D, *Figure 6*). The 100 pF capacitor provides a frequency adaptive trim to A3's trip point, aiding V/F linearity at high frequencies by compensating A3's relatively slow response time when used as a comparator. The 10 pF capacitor provides AC positive feedback to A3's positive input (Trace C, *Figure 6*). The positive output of A3 is inverted by the 2N2369 transistor which also has the effect of further shortening A3's response time. It does this by using a heavy feed-forward capacitor in its base drive line. This allows the transistor to complete switching just barely after the A3 output has begun to move! (Trace E, *Figure 6*). The 2N2369's negative output turns off the 2N4393 FET. This lifts A1's "+" input from ground and causes A1 to become a unity gain follower. This forces A1's output to immediately slew to the value of E_{IN} . This causes the A2 integrator to reverse in direction, forming a triangle wave. When A2 ramps far enough negative A3 will again switch and the entire cycle will repeat. The triangle output at A2 is fed to the discrete transistors which form a sine shaper. This configuration uses the logarithmic relationship between collector current and V_{BE} in transistors to smooth the triangle wave. The last amplifier in the quad package provides gain and buffering and furnishes the sine wave output (Trace F, *Figure 6*).



TL/H/6932-6

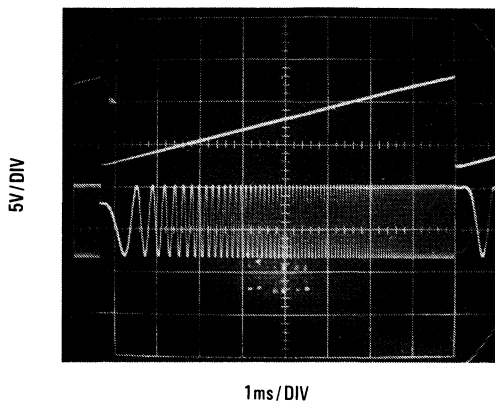
Trace	Vertical	Horizontal
A	20V/Div	
B	20V/Div	
C	10V/Div	
D	20V/Div	20 μ s/Div
E	50V/Div	
F	2V/Div	
G	0.2V/Div	

FIGURE 6. Waveforms from the oscillator shown in *Figure 5* show that upon receiving A1's negative voltage (Trace A), A2 ramps in a positive direction (B).

This ramp joins the AC feedback delivered to A3's positive input (C); Trace D depicts A3's positive-going output. This output in turn is inverted by the 2N2369 transistor (E), which turns off the 2N4393 and drives A1's positive input above ground. A2's triangle output also connects to four sine-shaper transistors and A4 and finally emerges as the circuit's sine wave output (F). A distortion analyzer's output (G) shows the circuit's minimum distortion products after trimming.

To calibrate the circuit apply 10V to the input and adjust the wave shape trim and symmetry trim for minimum distortion on a distortion analyzer. Next, adjust the input voltage for an output frequency of 10 Hz and trim the low frequency distortion potentiometer for minimum indication on the distortion analyzer. Finally, alternately adjust the zero and full-scale potentiometers so that inputs of 500 μ V and 10V yield respective outputs of 1 Hz and 20 kHz. Distortion products are shown in Trace G, *Figure 6*.

This circuit provides an unusually clean and wide ranging response to rapidly changing inputs, something most sine wave oscillators cannot do. *Figure 7* shows the circuit's response to a 10V ramp applied to the input. The output is singularly clean, with no untoward dynamics, even during or following the high speed reset of the ramp.



TL/H/6932-7

FIGURE 7. Applying a 10V ramp input (top trace) to the *Figure 5* circuit's input produces an extremely clean output (bottom trace) with no glitches, ringing or overshoot, even during or after the ramp's high speed reset.

SINE WAVE VOLTAGE REFERENCE

Figure 8 depicts a simple and economical sine wave circuit which provides a fixed 1 kHz output with a precise 2.50 Vrms amplitude. The circuit may be used as inexpensive AC calibration source or anywhere an amplitude stabilized AC source is required. Q1 is set up in a phase shift oscillator configuration and oscillates at 1 kHz. The sine wave at Q1's collector is AC coupled to A1, which has a closed loop gain of about 5. A1's output, which is the circuit's output, is half-wave rectified by the diode and a DC potential appears across the 1 μ F capacitor.

This positive voltage is compared by A2 to a voltage derived from the LM329 reference. The diode in the potentiometer wiper arm compensates the rectifying diode. The diode in A2's feedback loop prevents negative voltages from being applied to Q1 (and the feedback capacitor, an electrolytic) on start-up. A2 amplifies the difference of the reference and output signals at a gain of 10. The output of A2 is used to provide collector bias for Q1, completing an amplitude stabilizing feedback loop around the oscillator. The 2 μ F electrolytic provides stable loop compensation. The 5 k Ω potentiometer is adjusted so that the circuit output is exactly 2.50V. This output will show less than 1 mV shift for ± 5 V variation in either supply. Drift is typically 250 μ V/ $^{\circ}$ C and distortion is inside 1%.

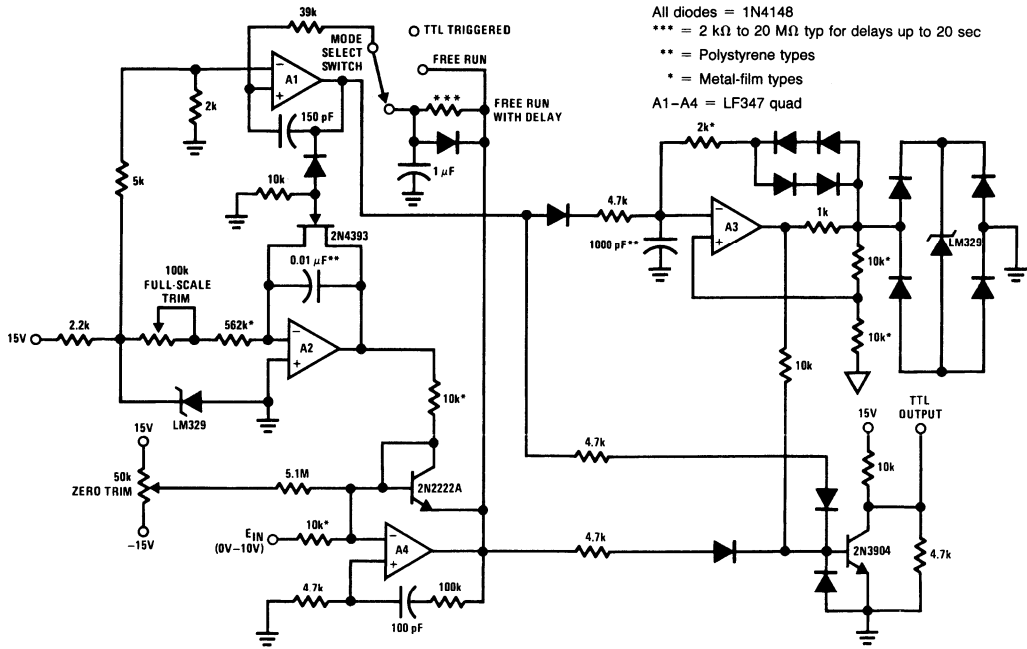
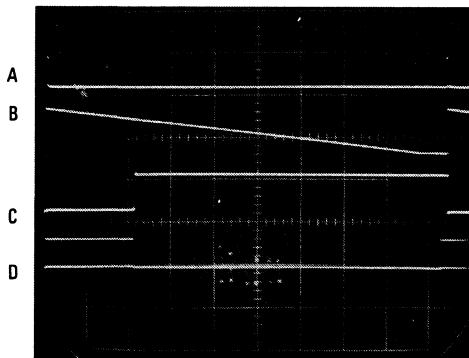


FIGURE 9. Three mode select switch positions offer a choice of internal or external trigger conditions for this integrating A/D converter. Over 15°C to 35°C, this trimmable converter provides a 10-bit serial output, converts in 10 ms and accepts 0V to 10V inputs.

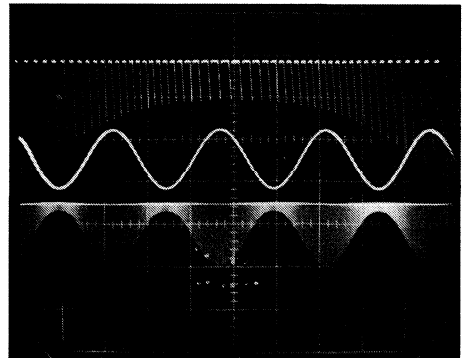
TL/H/6932-9



TL/H/6932-10

Trace	Vertical	Horizontal
A	5V/Div	
B	10V/Div	1 ms/Div
C	10V/Div	
D	5V/Div	

FIGURE 10. Depicting the operation of *Figure 9's* A/D circuit in "free run with delay" mode, Trace A shows A1's output low. In this state, integrator A2 starts to ramp in a negative-going direction (Trace B). When A2's ramp potential barely exceeds the input voltage's negative value, A4's output goes high (C). This transition turns on the 2N3904 transistor, which shuts off the TTL output pulse train (D).



TL/H/6932-11

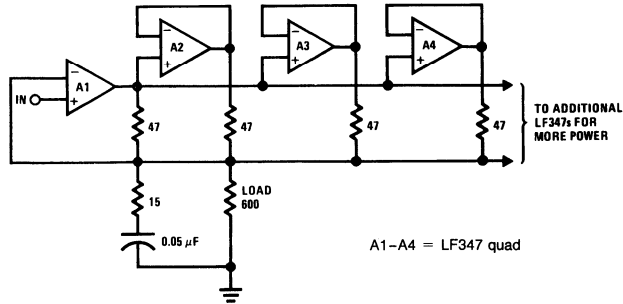
Trace	Vertical	Horizontal
A	1V/Div	2 ms/Div
B	5V/Div	20 ms/Div
C	5V/Div	20 ms/Div

FIGURE 11. Illustrating the A/D converter's operation in the "free run" mode, Trace B shows a positively biased sine wave input. Because reset and self trigger occur instantly after conversion, A2's output produces a ramp-constructed envelope of the input (Trace C). Trace A shows a time expanded form of the envelope waveform.

HIGH OUTPUT CURRENT AMPLIFIER

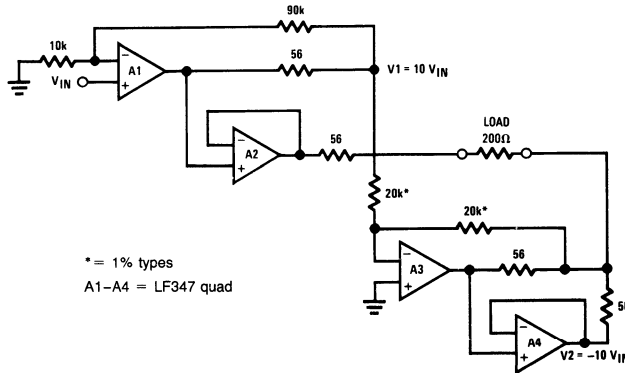
Figure 12 shows a scheme for obtaining high output current into a load by using all 4 amplifiers in an LF347 to supply output power. It operates on the principle that all the amplifiers have to supply the same current as A1, whether that current is plus, minus or zero. A single LF347 can be used to drive a 600Ω load to ±11V in this fashion. Two LF347

packages permit ±40 mA of output current. The series RC damper prevents oscillations. The circuit of Figure 13 is similar but features a gain of 10 and output to a floating load. A1 amplifies the signal and A2 helps it drive the load. A3 operates as a unity gain inverter and A4 helps it to drive the load. This circuit will easily drive a 2000Ω floating load to ±20V.



TL/H/6932-12

FIGURE 12. Utilizing current-amplifying capabilities, one LF347 can drive a 600Ω load to ±11V. For additional power, two LF347's can supply an output current of ±40 mA.



TL/H/6932-13

FIGURE 13. Configured as a high output current amplifier with a gain of 10, this LF347 circuit can drive a 200Ω floating load to ±20V.

Sine Wave Generation Techniques



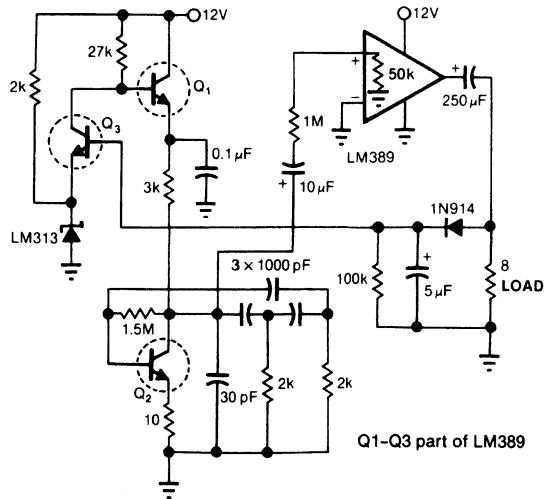
Producing and manipulating the sine wave function is a common problem encountered by circuit designers. Sine wave circuits pose a significant design challenge because they represent a constantly controlled linear oscillator. Sine wave circuitry is required in a number of diverse areas, including audio testing, calibration equipment, transducer drives, power conditioning and automatic test equipment (ATE). Control of frequency, amplitude or distortion level is often required and all three parameters must be simultaneously controlled in many applications.

A number of techniques utilizing both analog and digital approaches are available for a variety of applications. Each individual circuit approach has inherent strengths and weaknesses which must be matched against any given application (see table).

PHASE SHIFT OSCILLATOR

A simple inexpensive amplitude stabilized phase shift sine wave oscillator which requires only one IC package and runs off a single supply appears in *Figure 1*. The LM389 audio power amplifier package contains three discrete NPN transistors in addition to the amplifier. Q2, in combination

with the RC network comprises a phase shift configuration and oscillates at about 12 kHz. The remaining circuitry provides amplitude stability. The high impedance output at Q2's collector is fed to the input of the LM389 via the 10 μ F-1M series network. The 1M resistor in combination with the internal 50 k Ω unit in the LM389 divides Q2's output by 20. This is necessary because the LM389 has a fixed gain of 20. In this manner the amplifier functions as a unity gain current buffer which will drive an 8 Ω load. The positive peaks at the amplifier output are rectified and stored in the 5 μ F capacitor. Q3's collector current will vary with the difference between its base and emitter voltages. Since the emitter voltage is fixed by the LM313 1.2V reference, Q3 performs a comparison function and its collector current modulates Q1's base voltage. Q1, an emitter follower, provides servo controlled drive to the Q2 oscillator. If the emitter of Q2 is opened up and driven by a control voltage, the amplitude of the circuit output may be varied. The LM389 output will drive 5V (1.75 Vrms) peak-to-peak into 8 Ω with about 2% distortion. A ± 3 V power supply variation causes less than ± 0.1 dB amplitude shift at the output.



TL/H/7483-1

FIGURE 1. Phase-shift sine wave oscillators combine simplicity with versatility. This 12 kHz design can deliver 5 Vp-p to the 8 Ω load with about 2% distortion.

Sine-Wave-Generation Techniques

Type	Typical Frequency Range	Typical Distortion (%)	Typical Amplitude Stability (%)	Comments
Phase Shift	10 Hz–1 MHz	1–3	3 (Tighter with Servo Control)	Simple, inexpensive technique. Easily amplitude servo controlled. Resistively tunable over 2:1 range with little trouble. Good choice for cost-sensitive, moderate-performance applications. Quick starting and settling.
Wein Bridge	1 Hz–1 MHz	0.01	1	Extremely low distortion. Excellent for high-grade instrumentation and audio applications. Relatively difficult to tune—requires dual variable resistor with good tracking. Take considerable time to settle after a step change in frequency or amplitude.
LC Negative Resistance	1 kHz–10 MHz	1–3	3	Difficult to tune over wide ranges. Higher Q than RC types. Quick starting and easy to operate in high frequency ranges.
Tuning Fork	60 Hz–3 kHz	0.25	0.01	Frequency-stable over wide ranges of temperature and supply voltage. Relatively unaffected by severe shock or vibration. Basically untunable.
Crystal	30 kHz–200 MHz	0.1	1	Highest frequency stability. Only slight (ppm) tuning possible. Fragile.
Triangle-Driven Break-Point Shaper	< 1 Hz–500 kHz	1–2	1	Wide tuning range possible with quick settling to new frequency or amplitude.
Triangle-Driven Logarithmic Shaper	< 1 Hz–500 kHz	0.3	0.25	Wide tuning range possible with quick settling to new frequency or amplitude. Triangle and square wave also available. Excellent choice for general-purpose requirements needing frequency-sweep capability with low-distortion output.
DAC-Driven Logarithmic Shaper	< 1 Hz–500 kHz	0.3	0.25	Similar to above but DAC-generated triangle wave generally easier to amplitude-stabilize or vary. Also, DAC can be addressed by counters synchronized to a master system clock.
ROM-Driven DAC	1 Hz–20 MHz	0.1	0.01	Powerful digital technique that yields fast amplitude and frequency slewing with little dynamic error. Chief detriments are requirements for high-speed clock (e.g., 8-bit DAC requires a clock that is $256 \times$ output sine wave frequency) and DAC glitching and settling, which will introduce significant distortion as output frequency increases.

LOW DISTORTION OSCILLATION

In many applications the distortion levels of a phase shift oscillator are unacceptable. Very low distortion levels are provided by Wein bridge techniques. In a Wein bridge stable oscillation can only occur if the loop gain is maintained at unity at the oscillation frequency. In *Figure 2a* this is achieved by using the positive temperature coefficient of a small lamp to regulate gain as the output attempts to vary. This is a classic technique and has been used by numerous circuit designers* to achieve low distortion. The smooth lim-

iting action of the positive temperature coefficient bulb in combination with the near ideal characteristics of the Wein network allow very high performance. The photo of *Figure 3* shows the output of the circuit of *Figure 2a*. The upper trace is the oscillator output. The middle trace is the downward slope of the waveform shown greatly expanded. The slight aberration is due to crossover distortion in the FET-input LF155. This crossover distortion is almost totally responsible for the sum of the measured 0.01% distortion in this

*Including William Hewlett and David Packard who built a few of these type circuits in a Palo Alto garage about forty years ago.

oscillator. The output of the distortion analyzer is shown in the bottom trace. In the circuit of *Figure 2b*, an electronic equivalent of the light bulb is used to control loop gain. The zener diode determines the output amplitude and the loop time constant is set by the 1M-2.2 μF combination.

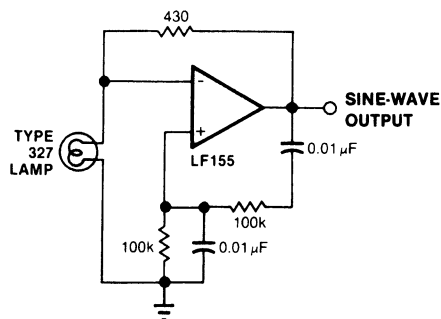
The 2N3819 FET, biased by the voltage across the 2.2 μF capacitor, is used to control the AC loop gain by shunting the feedback path. This circuit is more complex than *Figure 2a* but offers a way to control the loop time constant while maintaining distortion performance almost as good as in *Figure 2a*.

HIGH VOLTAGE AC CALIBRATOR

Another dimension in sine wave oscillator design is stable control of amplitude. In this circuit, not only is the amplitude stabilized by servo control but voltage gain is included within the servo loop.

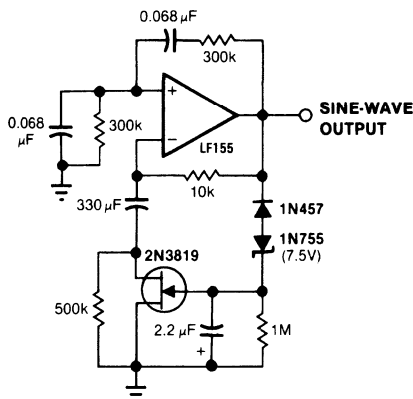
A 100 Vrms output stabilized to 0.025% is achieved by the circuit of *Figure 4*. Although complex in appearance this circuit requires just 3 IC packages. Here, a transformer is used to provide voltage gain within a tightly controlled servo

loop. The LM3900 Norton amplifiers comprise a 1 kHz amplitude controllable oscillator. The LH0002 buffer provides low impedance drive to the LS-52 audio transformer. A voltage gain of 100 is achieved by driving the secondary of the transformer and taking the output from the primary. A current-sensitive negative absolute value amplifier composed of two amplifiers of an LF347 quad generates a negative rectified feedback signal. This is compared to the LM329 DC reference at the third LF347 which amplifies the difference at a gain of 100. The 10 μF feedback capacitor is used to set the frequency response of the loop. The output of this amplifier controls the amplitude of the LM3900 oscillator thereby closing the loop. As shown the circuit oscillates at 1 kHz with under 0.1% distortion for a 100 Vrms (285 Vp-p) output. If the summing resistors from the LM329 are replaced with a potentiometer the loop is stable for output settings ranging from 3 Vrms to 190 Vrms (542 Vp-p) with no change in frequency. If the DAC1280 D/A converter shown in dashed lines replaces the LM329 reference, the AC output voltage can be controlled by the digital code input with 3 digit calibrated accuracy.



TL/H/7483-2

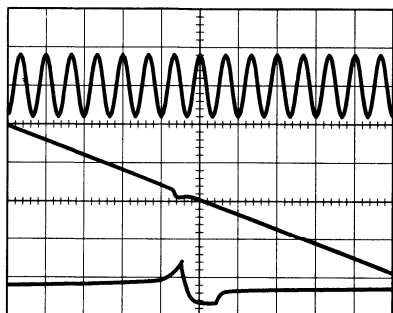
(a)



TL/H/7483-3

(b)

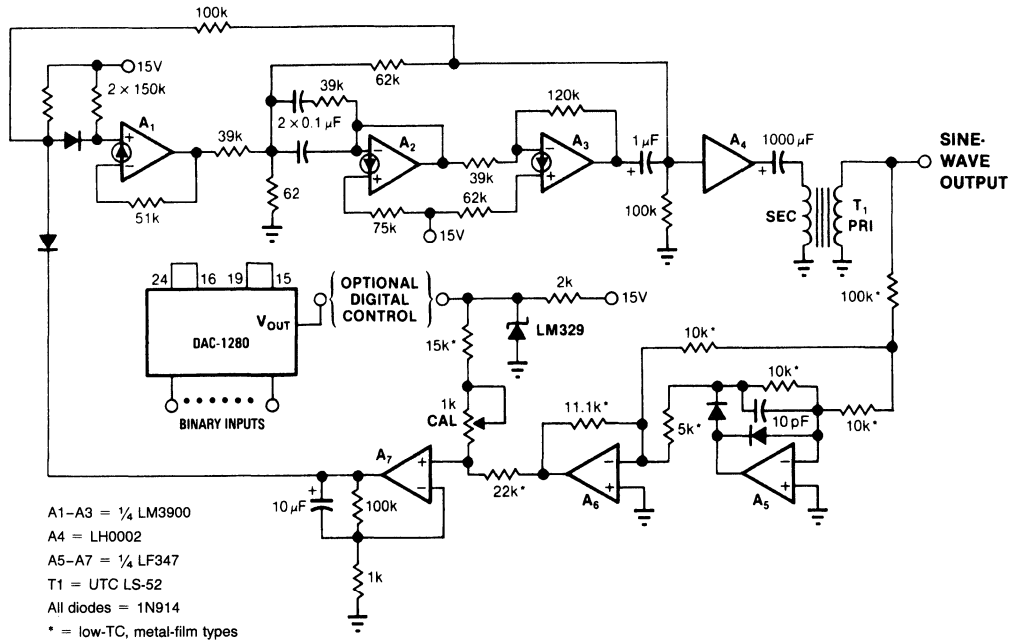
FIGURE 2. A basic Wein bridge design (a) employs a lamp's positive temperature coefficient to achieve amplitude stability. A more complex version (b) provides the same feature with the additional advantage of loop time-constant control.



TL/H/7483-4

FIGURE 3. Low-distortion output (top trace) is a Wein bridge oscillator feature. The very low crossover distortion level (middle) results from the LF155's output stage. A distortion analyzer's output signal (bottom) indicates this design's 0.01% distortion level.

Trace	Vertical	Horizontal
Top	10V/DIV	10 ms/DIV
Middle	1V/DIV	500 ns/DIV
Bottom	0.5V/DIV	500 ns/DIV



TL/H/7483-5

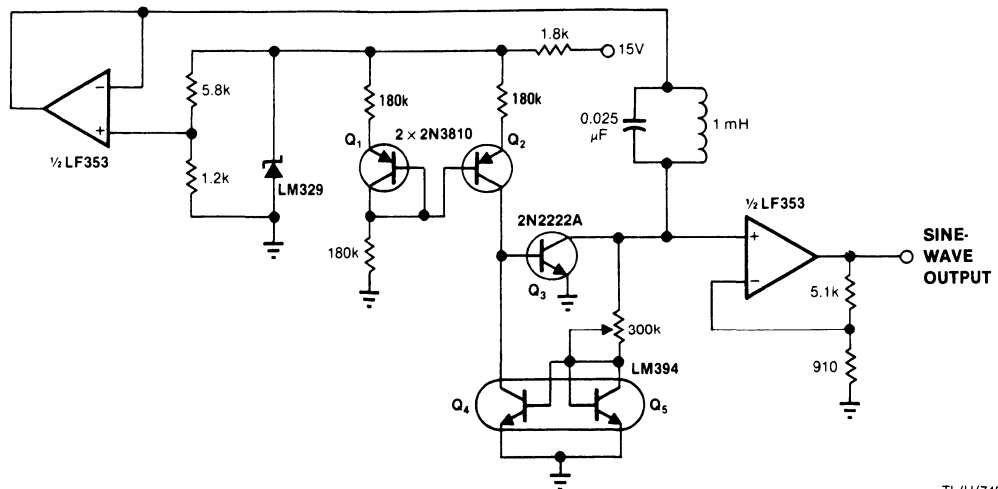
FIGURE 4. Generate high-voltage sine waves using IC-based circuits by driving a transformer in a step-up mode. You can realize digital amplitude control by replacing the LM329 voltage reference with the DAC1287.

NEGATIVE RESISTANCE OSCILLATOR

All of the preceding circuits rely on RC time constants to achieve resonance. LC combinations can also be used and offer good frequency stability, high Q and fast starting.

In Figure 5 a negative resistance configuration is used to generate the sine wave. The Q1-Q2 pair provides a 15 μ A current source. Q2's collector current sets Q3's peak collector current. The 300 k Ω resistor and the Q4-Q5 LM394

matched pair accomplish a voltage-to-current conversion that decreases Q3's base current when its collector voltage rises. This negative resistance characteristic permits oscillation. The frequency of operation is determined by the LC in the Q3-Q5 collector line. The LF353 FET amplifier provides gain and buffering. Power supply dependence is eliminated by the zener diode and the LF353 unity gain follower. This circuit starts quickly and distortion is inside 1.5%.



TL/H/7483-6

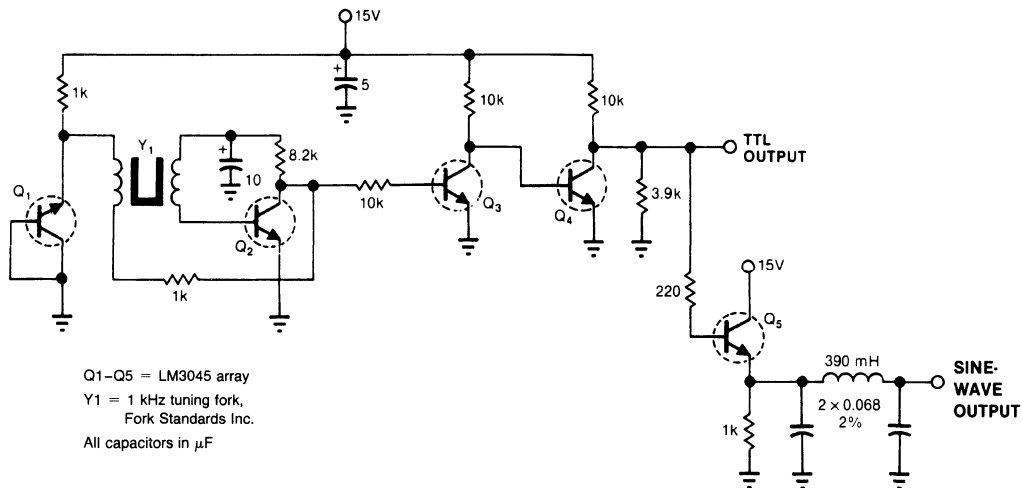
FIGURE 5. LC sine wave sources offer high stability and reasonable distortion levels. Transistors Q1 through Q5 implement a negative-resistance amplifier. The LM329, LF353 combination eliminates power-supply dependence.

RESONANT ELEMENT OSCILLATOR—TUNING FORK

All of the above oscillators rely on combinations of passive components to achieve resonance at the oscillation frequency. Some circuits utilize inherently resonant elements to achieve very high frequency stability. In *Figure 6* a tuning fork is used in a feedback loop to achieve a stable 1 kHz output. Tuning fork oscillators will generate stable low frequency sine outputs under high mechanical shock conditions which would fracture a quartz crystal.

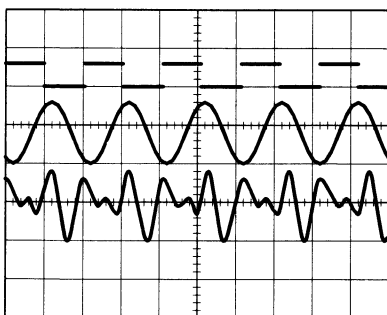
Because of their excellent frequency stability, small size and low power requirements, they have been used in airborne applications, remote instrumentation and even watches. The low frequencies achievable with tuning forks are not

available from crystals. In *Figure 6*, a 1 kHz fork is used in a feedback configuration with Q2, one transistor of an LM3045 array. Q1 provides zener drive to the oscillator circuit. The need for amplitude stabilization is eliminated by allowing the oscillator to go into limit. This is a conventional technique in fork oscillator design. Q3 and Q4 provide edge speed-up and a 5V output for TTL compatibility. Emitter follower Q5 is used to drive an LC filter which provides a sine wave output. *Figure 6a*, trace A shows the square wave output while trace B depicts the sine wave output. The 0.7% distortion in the sine wave output is shown in trace C, which is the output of a distortion analyzer.



TL/H/7483-7

FIGURE 6. Tuning fork based oscillators don't inherently produce sinusoidal outputs. But when you do use them for this purpose, you achieve maximum stability when the oscillator stage (Q1, Q2) limits. Q3 and Q4 provide a TTL compatible signal, which Q5 then converts to a sine wave.



TL/H/7483-8

Trace	Vertical	Horizontal
Top	5V/DIV	500 μs /DIV
Middle	50V/DIV	
Bottom	0.2V/DIV	

FIGURE 6a. Various output levels are provided by the tuning fork oscillator shown in *Figure 6*. This design easily produces a TTL compatible signal (top trace) because the oscillator is allowed to limit. Low-pass filtering this square wave generates a sine wave (middle). The oscillator's 0.7% distortion level is indicated (bottom) by an analyzer's output.

RESONANT ELEMENT OSCILLATOR—QUARTZ CRYSTAL

Quartz crystals allow high frequency stability in the face of changing power supply and temperature parameters. *Figure 7a* shows a simple 100 kHz crystal oscillator. This Colpitts class circuit uses a JFET for low loading of the crystal, aiding stability. Regulation will eliminate the small effects (~ 5 ppm for 20% shift) that supply variation has on this circuit. Shunting the crystal with a small amount of capacitance allows very fine trimming of frequency. Crystals typically drift less than 1 ppm/ $^{\circ}$ C and temperature controlled ovens can be used to eliminate this term (*Figure 7b*). The RC feedback values will depend upon the thermal time constants of the oven used. The values shown are typical. The temperature of the oven should be set so that it coincides with the crystal's zero temperature coefficient or "turning point" temperature which is manufacturer specified. An alternative to temperature control uses a varactor diode placed across the

crystal. The varactor is biased by a temperature dependent voltage from a circuit which could be very similar to *Figure 7b* without the output transistor. As ambient temperature varies the circuit changes the voltage across the varactor, which in turn changes its capacitance. This shift in capacitance trims the oscillator frequency.

APPROXIMATION METHODS

All of the preceding circuits are *inherent* sine wave generators. Their normal mode of operation supports and maintains a sinusoidal characteristic. Another class of oscillator is made up of circuits which *approximate* the sine function through a variety of techniques. This approach is usually more complex but offers increased flexibility in controlling amplitude and frequency of oscillation. The capability of this type of circuit for a digitally controlled interface has markedly increased the popularity of the approach.

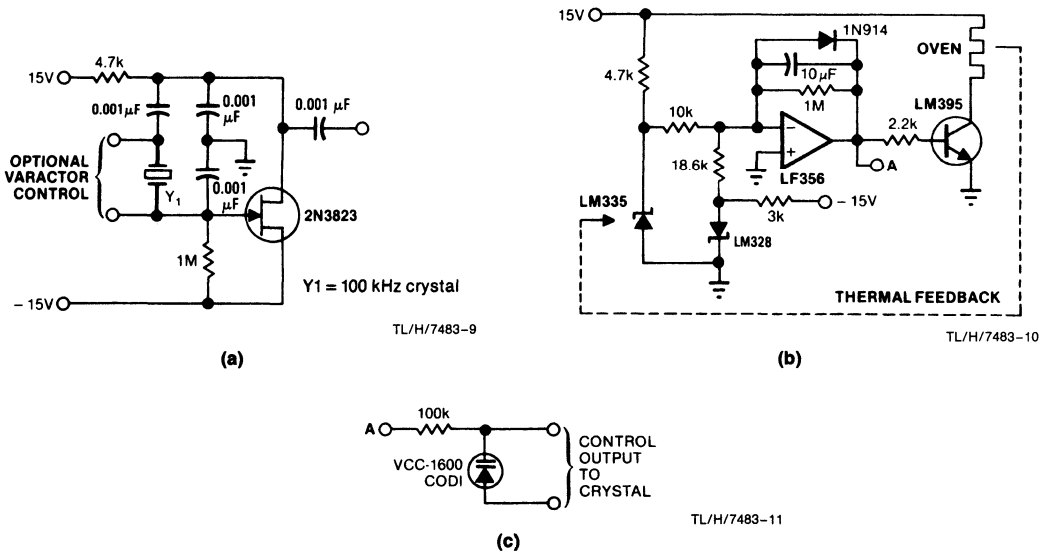
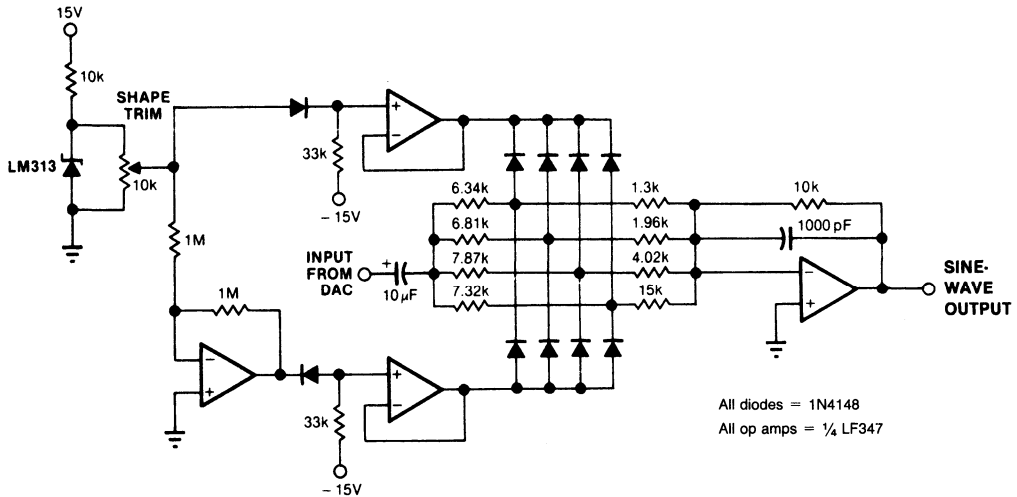


FIGURE 7. Stable quartz-crystal oscillators can operate with a single active device (a). You can achieve maximum frequency stability by mounting the oscillator in an oven and using a temperature-controlling circuit (b). A varactor network (c) can also accomplish crystal fine tuning. Here, the varactor replaces the oven and retunes the crystal by changing its load capacitances.

SINE APPROXIMATION—BREAKPOINT SHAPER

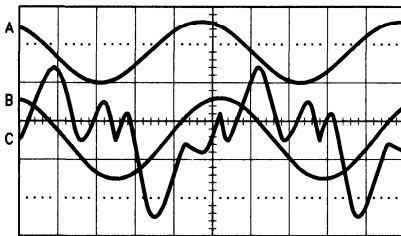
Figure 8 diagrams a circuit which will "shape" a 20 Vp-p wave input into a sine wave output. The amplifiers serve to establish stable bias potentials for the diode shaping network. The shaper operates by having individual diodes turn on or off depending upon the amplitude of the input triangle. This changes the gain of the output amplifier and gives the circuit its characteristic non-linear, shaped output response. The values of the resistors associated with the diodes determine the shaped waveform's appearance. Individual diodes in the DC bias circuitry provide first order temperature compensation for the shaper diodes. Figure 9 shows the circuit's

performance. Trace A is the filtered output (note 1000 pF capacitor across the output amplifier). Trace B shows the waveform with no filtering (1000 pF capacitor removed) and trace C is the output of a distortion analyzer. In trace B the breakpoint action is just detectable at the top and bottom of the waveform, but all the breakpoints are clearly identifiable in the distortion analyzer output of trace C. In this circuit, if the amplitude or symmetry of the input triangle wave shifts, the output waveform will degrade badly. Typically, a D/A converter will be used to provide input drive. Distortion in this circuit is less than 1.5% for a filtered output. If no filter is used, this figure rises to about 2.7%.



TL/H/7483-12

FIGURE 8. Breakpoint shaping networks employ diodes that conduct in direct proportion to an input triangle wave's amplitude. This action changes the output amplifier's gain to produce the sine function.



TL/H/7483-13

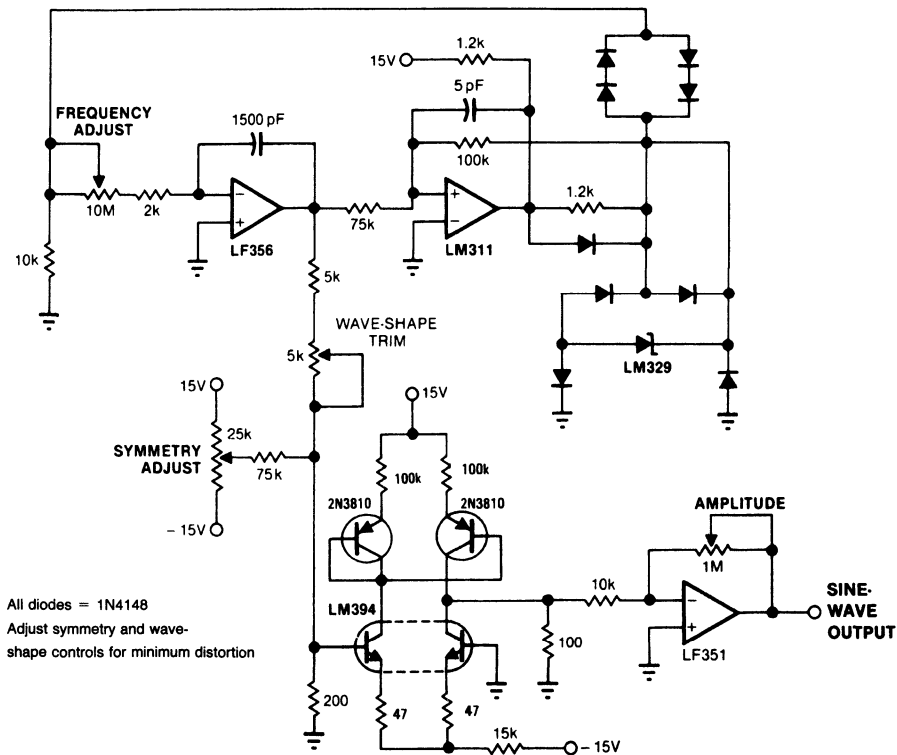
Trace	Vertical	Horizontal
A	5V/DIV	
B	5V/DIV	20 µs/DIV
C	0.5V/DIV	

FIGURE 9. A clean sine wave results (trace A) when Figure 8's circuit's output includes a 1000 pF capacitor. When the capacitor isn't used, the diode network's breakpoint action becomes apparent (trace B). The distortion analyzer's output (trace C) clearly shows all the breakpoints.

SINE APPROXIMATION—LOGARITHMIC SHAPING

Figure 10 shows a complete sine wave oscillator which may be tuned from 1 Hz to 10 kHz with a single variable resistor. Amplitude stability is inside $0.02\%/^{\circ}\text{C}$ and distortion is 0.35%. In addition, desired frequency shifts occur instantaneously because no control loop time constants are employed. The circuit works by placing an integrator inside the positive feedback loop of a comparator. The LM311 drives symmetrical, temperature-compensated clamp arrangement. The output of the clamp biases the LF356 integrator. The LF356 integrates this current into a linear ramp at its

output. This ramp is summed with the clamp output at the LM311 input. When the ramp voltage nulls out the bound voltage, the comparator changes state and the integrator output reverses. The resultant, repetitive triangle waveform is applied to the sine shaper configuration. The sine shaper utilizes the non-linear, logarithmic relationship between V_{be} and collector current in transistors to smooth the triangle wave. The LM394 dual transistor is used to generate the actual shaping while the 2N3810 provides current drive. The LF351 allows adjustable, low impedance, output amplitude control. Waveforms of operation are shown in Figure 11.



TL/H/7483-14

FIGURE 10a. Logarithmic shaping schemes produce a sine wave oscillator that you can tune from 1 Hz to 10 kHz with a single control. Additionally, you can shift frequencies rapidly because the circuit contains no control-loop time constants.

SINE APPROXIMATION—VOLTAGE CONTROLLED SINE OSCILLATOR

Figure 10b details a modified but extremely powerful version of Figure 10. Here, the input voltage to the LF356 integrator is furnished from a control voltage input instead of the zener diode bridge. The control input is inverted by the LF351. The two complementary voltages are each gated by the 2N4393 FET switches, which are controlled by the LM311 output. The frequency of oscillation will now vary in direct propor-

tion to the control input. In addition, because the amplitude of this circuit is controlled by limiting, rather than a servo loop, response to a control step or ramp input is almost instantaneous. For a 0V–10V input the output will run over 1 Hz to 30 kHz with less than 0.4% distortion. In addition, linearity of control voltage vs output frequency will be within 0.25%. Figure 10c shows the response of this circuit (waveform B) to a 10V ramp (waveform A).

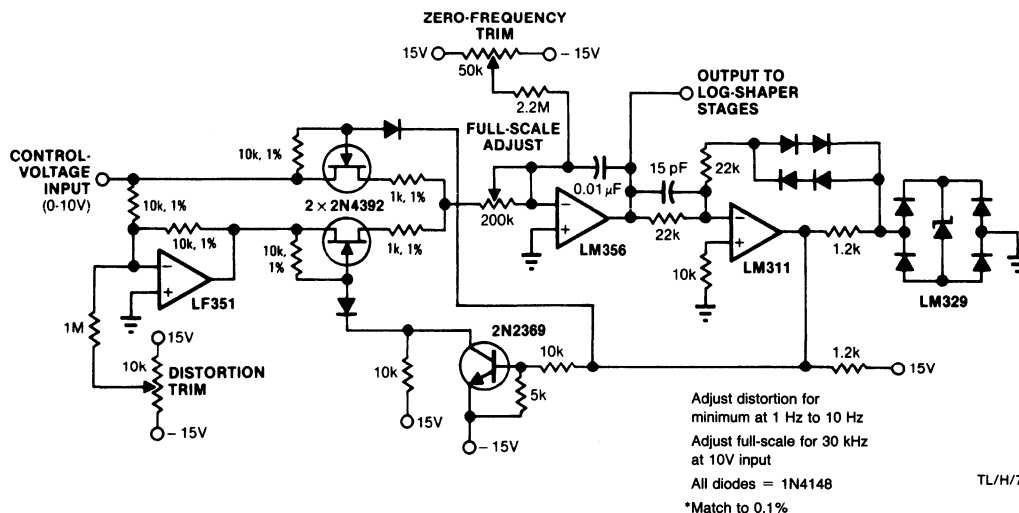
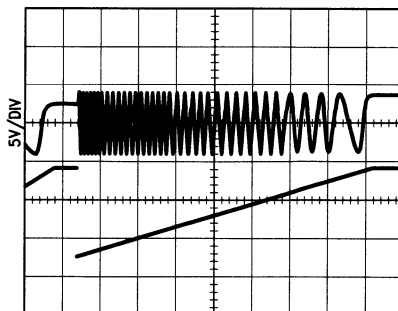


FIGURE 10b. A voltage-tunable oscillator results when Figure 10a's design is modified to include signal-level-controlled feedback. Here, FETs switch the integrator's input so that the resulting summing-junction current is a function of the input control voltage. This scheme realizes a frequency range of 1 Hz to 30 kHz for a 0V to 10V input.



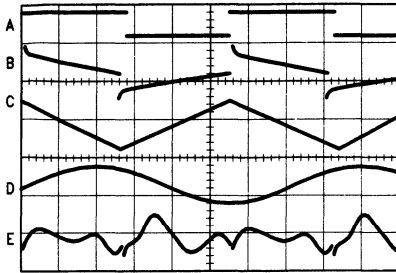
TL/H/7483-16

FIGURE 10c. Rapid frequency sweeping is an inherent feature of Figure 10b's voltage-controlled sine wave oscillator. You can sweep this VCO from 1 Hz to 30 kHz with a 10V input signal; the output settles quickly.

SINE APPROXIMATION—DIGITAL METHODS

Digital methods may be used to approximate sine wave operation and offer the greatest flexibility at some increase in complexity. *Figure 12* shows a 10-bit IC D/A converter driven from up/down counters to produce an amplitude-stable triangle current into the LF357 FET amplifier. The LF357 is used to drive a shaper circuit of the type shown in *Figure 10*. The output amplitude of the sine wave is stable and the frequency is solely dependent on the clock used to drive the counters. If the clock is crystal controlled, the output sine wave will reflect the high frequency stability of the crystal. In this example, 10 binary bits are used to drive the DAC so the output frequency will be 1/1024 of the clock frequency. If a sine coded read-only-memory is placed between the counter outputs and the DAC, the sine shaper may be elimi-

nated and the sine wave output taken directly from the LF357. This constitutes an extremely powerful digital technique for generating sine waves. The amplitude may be voltage controlled by driving the reference terminal of the DAC. The frequency is again established by the clock speed used and both may be varied at high rates of speed without introducing significant lag or distortion. Distortion is low and is related to the number of bits of resolution used. At the 8-bit level only 0.5% distortion is seen (waveforms, *Figure 13*; graph, *Figure 14*) and filtering will drop this below 0.1%. In the photo of *Figure 13* the ROM directed steps are clearly visible in the sine waveform and the DAC levels and glitching show up in the distortion analyzer output. Filtering at the output amplifier does an effective job of reducing distortion by taking out these high frequency components.



TL/H/7483-17

Trace	Vertical	Horizontal
A	20V/DIV	
B	20V/DIV	20 μ s/DIV
C	10V/DIV	
D	10V/DIV	
E	0.5V/DIV	

FIGURE 11. Logarithmic shapers can utilize a variety of circuit waveforms. The input to the LF356 integrator (*Figure 10*) appears here as trace A. The LM311's input (trace B) is the summed result of the integrator's triangle output (C) and the LM329's clamped waveform. After passing through the 2N3810/LM394 shaper stage, the resulting sine wave is amplified by the LF351 (D). A distortion analyzer's output (E) represents a 0.35% total harmonic distortion.

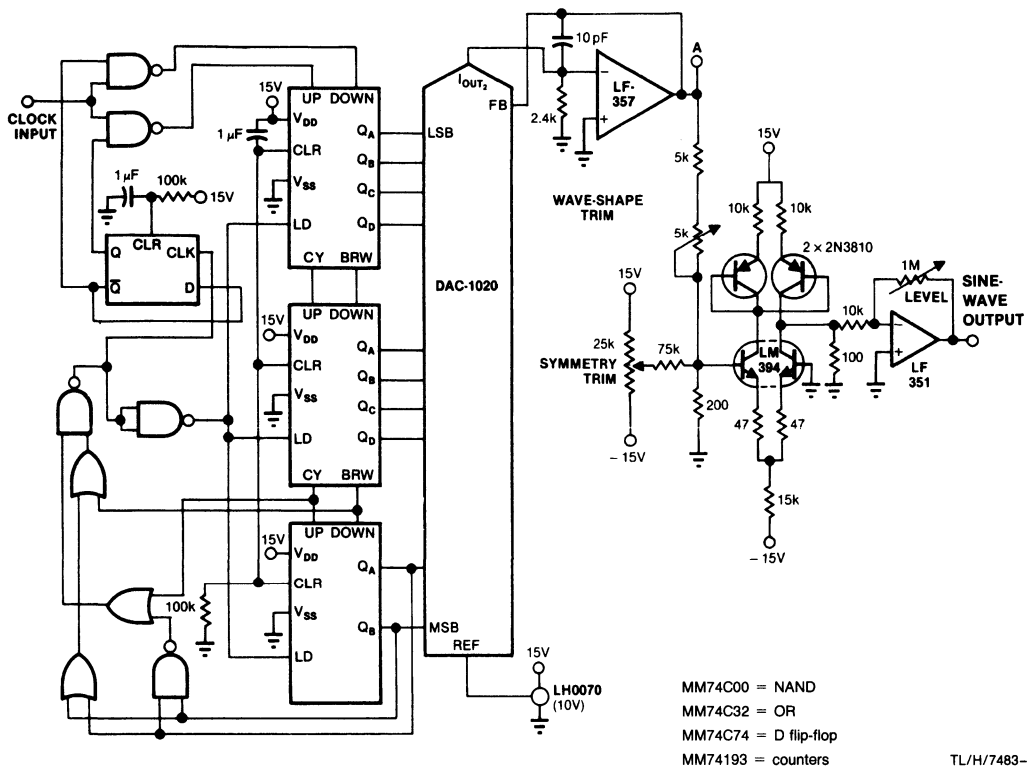
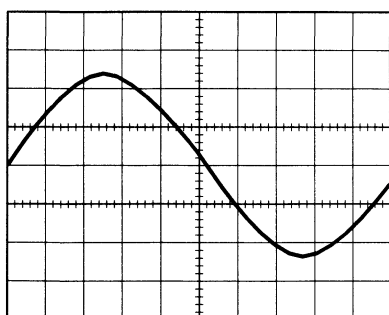


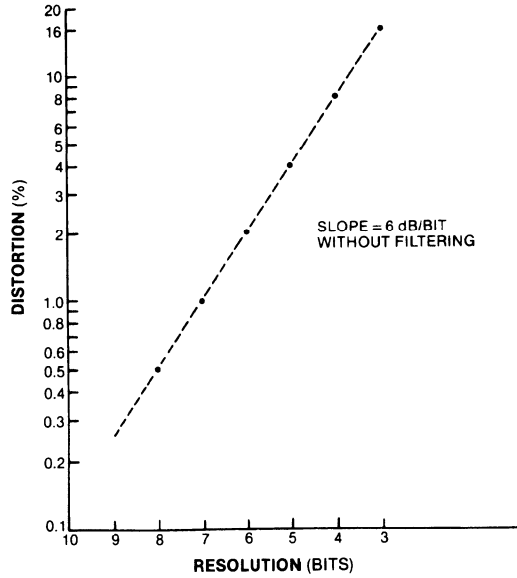
FIGURE 12. Digital techniques produce triangular waveforms that methods employed in *Figure 10a* can then easily convert to sine waves. This digital approach divides the input clock frequency by 1024 and uses the resultant 10 bits to drive a DAC. The DAC's triangular output—amplified by the LF357—drives the log shaper stage. You could also eliminate the log shaper and place a sine-coded ROM between the counters' outputs and the DAC, then recover the sine wave at point A.



Trace	Vertical	Horizontal
Sine Wave Analyzer	1V/DIV 0.2V/DIV	200 μs/DIV

TL/H/7483-19

FIGURE 13. An 8-bit sine coded ROM version of *Figure 12's* circuit produces a distortion level less than 0.5%. Filtering the sine output—shown here with a distortion analyzer's trace—can reduce the distortion to below 0.1%.



TL/H/7483-20

FIGURE 14. Distortion levels decrease with increasing digital word length. Although additional filtering can considerably improve the distortion levels (to 0.1% from 0.5% for the 8-bit case), you're better off using a long digital word.

Applications of Audio Amplifier—Transistor Array ICs

National Semiconductor
Application Note 264



The availability of extremely low cost audio amplifier ICs with on-chip transistor arrays allows designers a great deal of flexibility in designing audio circuits. The availability of the uncommitted transistors on the chip makes it easier and more economical to implement audio functions. One chip, the LM389, features a 250 mW audio amplifier and a 3 NPN transistor array (see "The LM389 Audio Amplifier—Transistor Array IC" drawing). The amplifier has differential inputs, separate pins for setting the gain via a resistor and runs from a single supply which may range from 4V to 15V. The 3 transistors have good beta over a wide range of collector currents and current handling capability of 25 mA. This combination of devices and features on a single, low priced chip

suggests that application areas unrelated to audio can be served. A good example appears in *Figure 1*.

DC-DC CONVERTER

The circuit in *Figure 1* uses the LM389 to provide a fully isolated $\pm 15V$ supply from a 5V line. This is useful in powering op amps and related circuitry in a primarily digital system. This circuit is intended for use in a digital system where it is necessary to supply $\pm 15V$ power to a small, low power load. Although units are available which will do this, they are designed to supply much more power than is required for many applications and are quite expensive. In this circuit, the LM389 amplifier is set up to oscillate at 20 kHz (Trace

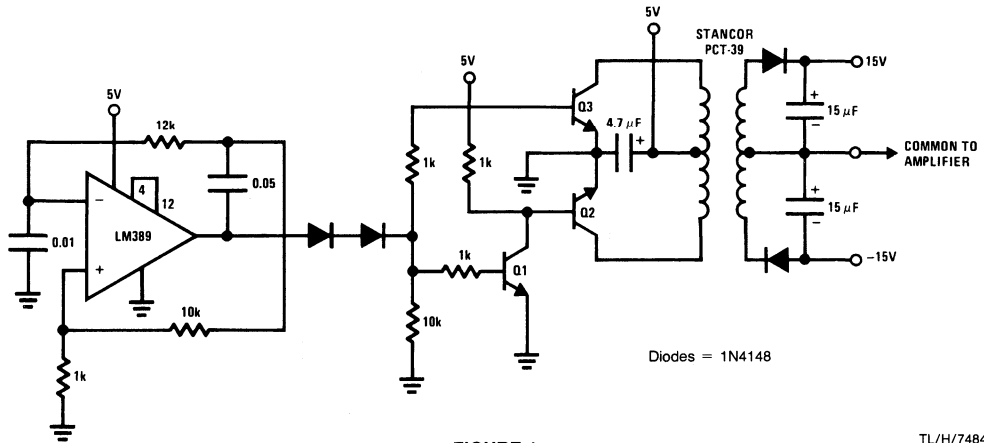
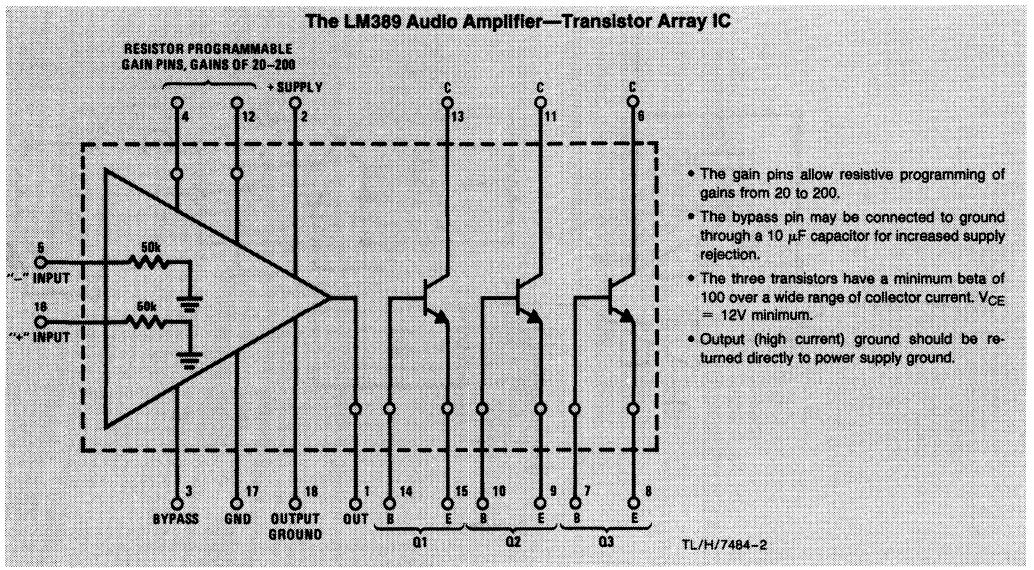


FIGURE 1

TL/H/7484-1



A, Figure 2). Each time the amplifier output changes state, the charging voltage supplied to the $0.01 \mu\text{F}$ capacitor reverses polarity, resulting in a triangle at the amplifier's negative input (Trace B, Figure 2). When the triangle potential crosses the voltage at the positive input, the output again changes state. The 20 kHz square wave output is fed to Q1 and Q3. Q1's inverted output drives Q2 while Q3 is used to drive half the transformer primary (Trace C, Figure 2). Q2 drives the other half of the transformer primary out of phase because of Q1's inversion (Trace D, Figure 2). The saturated switching of Q3 and Q2 is fast and clean (Q2 = Trace E, Figure 2; Q3 = Trace F, Figure 2; note horizontal sweep speed change) and results in an efficient voltage step-up across the transformer. The transformer output is rectified and filtered to produce complementary voltages which may be used to power the required linear components. This circuit will deliver $\pm 1.5 \text{ mA}$, enough to power an op amp or instrumentation amplifier in a signal conditioning application.

BI-STABLE TOUCH SWITCH

The circuit of Figure 3 allows a $115 \text{ V}_{\text{AC}}$ powered load to be controlled from a touch plate. The circuit's output is bi-stable and changes state each time the plate is touched. In operation, each time the touch plate is contacted the Q1 emitter follower conducts and its output is amplified by the LM389's amplifier, whose normally positive output (note the $10 \text{ M}\Omega$ bias resistor to "+" input) becomes a 60 Hz square wave. This causes the potential at the output of the $10 \text{ k}\Omega$ - $4.7 \mu\text{F}$ filter to jump sharply negative and remain there as long as the plate is touched. This negative step triggers a toggling flip-flop comprised of the remaining Q2 and Q3 LM389 transistors. In this manner, each time the touch plate is contacted the output of the flip-flop changes state. The flip-flop output is used to control a Triac or SCR which switches AC power to the load.

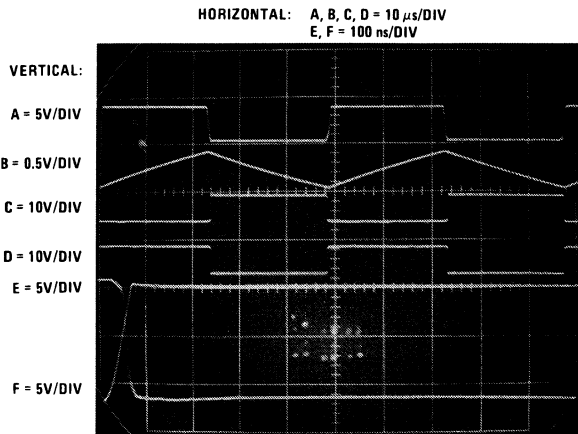


FIGURE 2

TL/H/7484-3

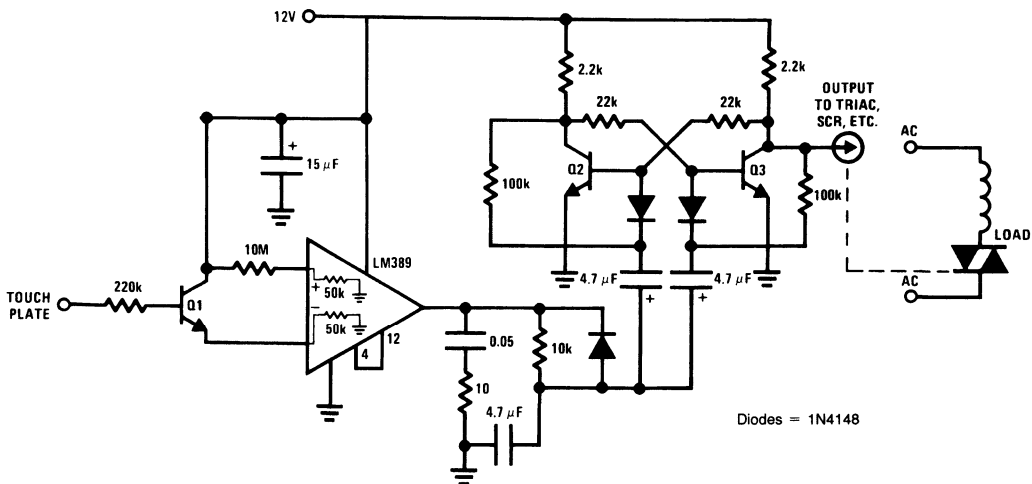


FIGURE 3

TL/H/7484-4

PORTABLE OSCILLOSCOPE CALIBRATOR

The circuit shown in *Figure 4* allows a quick check of an oscilloscope's time base and vertical calibration. It may be built into a small hand-held box and powered by a 12.5V battery, such as an Eveready type E-289. In this circuit the amplifier oscillates at 1 kHz. The 30 k Ω value should be trimmed for a precise (± 5 Hz) 1 kHz output. The amplifier output drives Q1 which provides very fast edges at Q2's base. Q2, an emitter follower, is used to drive Q3, which is connected in inverse mode and functions as a zener diode. Q3's breakdown potential is scaled by the 2k potentiometer to provide a 5.00V high square wave at the 5V output tap. The remaining resistors in the string furnish the 1V and 0.1V outputs. The 1 M Ω oscilloscope impedance does not introduce any appreciable loading error.

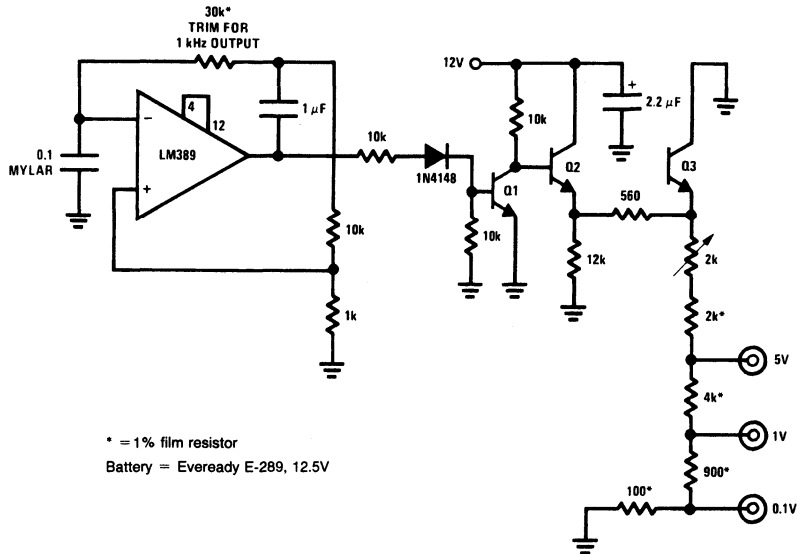


FIGURE 4

TL/H/7484-5

TUNING FORK STABILIZED FREQUENCY STANDARD

Figure 5 shows a circuit which provides a low frequency tuning fork stabilized output. Both sine wave and TTL compatible outputs are available. The circuit runs from 5V, which could be battery derived, due to the low power consumption. The tuning fork provides a direct low frequency output with very high stability (typically 5 ppm/ $^{\circ}$ C) with an initial accuracy of 0.01%. It will withstand vibration and shock which would fracture a quartz crystal. Q3 is set up in a feedback configuration which forces the tuning fork to oscillate at its resonant frequency. The signal at Q3's collector is squared up by Q1 and Q2, which provide a TTL compatible square wave at Q2's collector (Trace A, *Figure 6*). This square wave is also used to drive an LC filter whose output is a sine wave. The filter's output is unity gain amplified

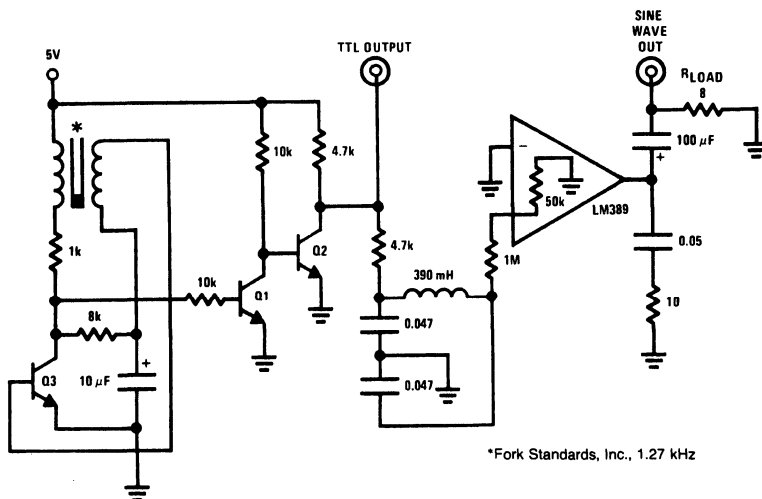


FIGURE 5

TL/H/7484-6

by the amplifier to provide a low impedance output (Trace B, Figure 6). The amplifier, which has a minimum gain of 20, is made to achieve apparent unity gain by the voltage divider created between the internal 50 k Ω resistor and the 1 M Ω unit in series with the positive input. The circuit's sine wave output, which will drive an 8 Ω load, has less than 1% distortion. Trace C, Figure 6 shows the output of a distortion analyzer connected to the sine wave output.

LOW DISTORTION OSCILLATOR

In Figure 7, the LM389 is used to produce a low distortion sine wave and a synchronous in-phase square wave output is also provided. The circuit's 1/4W output drive capability allows it

to drive loads such as transducer bridges. In such applications, the in-phase square wave output can be used to drive synchronous demodulation switches. The oscillator's low distortion (0.2%) is directly traceable to the use of a light bulb which provides smooth amplitude limiting for the Wein bridge network at the amplifier. In this example, oscillation frequency is 1 kHz. The in-phase square wave output is provided by the three transistors. Q1, operating in the common base configuration, is biased by the diode drop and the 100 Ω potentiometer. The resultant square wave at Q1's collector is used to drive the Q2-Q3 common emitter stages which provide edge speed-up. The potentiometer is adjusted so that the edges of the output square wave precisely line up with the zero crossings of the sine wave.

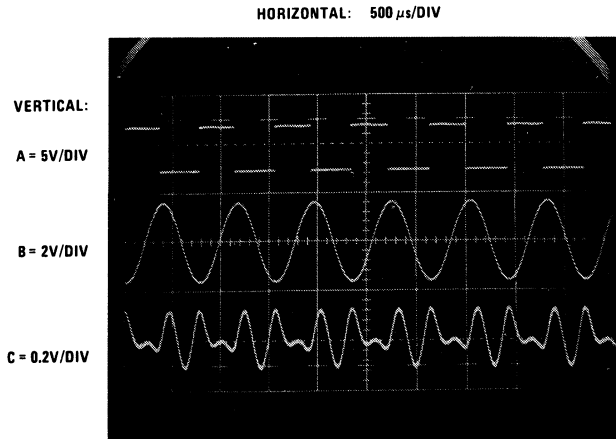


FIGURE 6

TL/H/7484-7

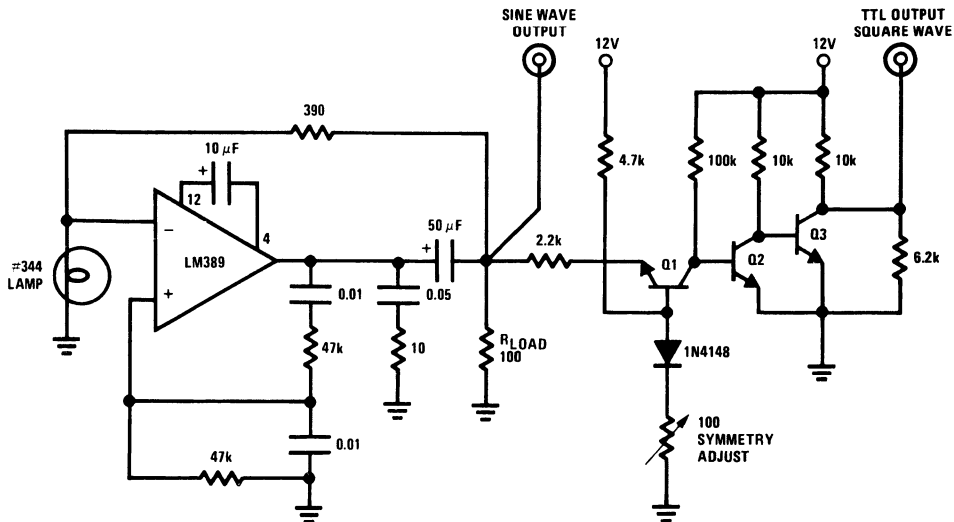


FIGURE 7

TL/H/7484-8

LOGARITHMIC AMPLIFIER

In Figure 8, the LM389 is used in an unorthodox fashion to build a logarithmic amplifier which eliminates the usual complex and expensive temperature compensation associated with such circuits. This allows the cost of the logarithmic amplifier function to be reduced by an order of magnitude compared to conventional approaches. Q3 functions as a chip temperature sensor while Q2 serves as a heater. The amplifier senses the temperature dependent V_{BE} of Q3 and drives Q2 to servo the chip temperature to the set point established by the 10 k Ω -1 k Ω divider string. The LM329 reference insures power supply independence of the temperature control. Q1, the logging transistor, operates in this tightly controlled thermal environment (typically 50°C) and is immune to ambient temperature shifts. The LM340L 12V regulator insures safe operation of the LM389, a 12V device. When the circuit is first turn ON, the voltage Q2's emitter is about 3.3V resulting in a current flow of 120 mA. This forces Q2 to dissipate about 1.5W which raises the chip to

operating temperature very rapidly. At this point the thermal servo takes control and backs the power down. The LM340L regulator has only 3V across it, so dissipation never exceeds more than about 0.3W. The zener at the base of Q2 prevents servo lock-up during circuit start-up. Because of the small size of the chip, warmup is quick and power consumption low.

To adjust this circuit, ground the base of Q2, apply circuit power and measure the collector potential of Q3 at known room temperature. Next, calculate what Q3's collector potential will be at 50°C, allowing -2.2 mV/°C. Select the 1k value to yield a voltage close to the calculated 50°C potential at the LM389's negative input. This can be a fairly loose trim, as the exact chip temperature is unimportant, so long as it is stable. Finally, unground Q2's base and the circuit will servo. This may be functionally checked by reading Q3's collector voltage and noting stability within 100 μ V (0.05°C) while blowing on A3.

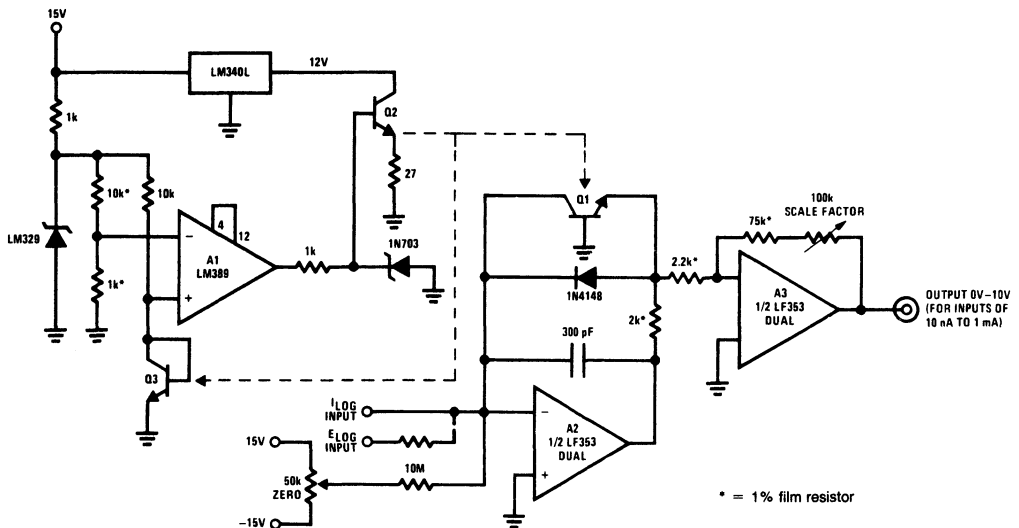


FIGURE 8

TL/H/7484-9

An Electronic Watt-Watt-Hour Meter

National Semiconductor
Application Note 265



The continued emphasis on energy conservation has forced designers to consider the power consumption and efficiency of their products. While equipment for the industrial market must be designed with attention towards these factors, the consumer area is even more critical. The high cost of electricity has promoted a great deal of interest in the expense of powering various appliances. The watt-watt-hour meter outlined in *Figure 1* allows the designer to easily determine power consumption of any 115V AC powered device. The extremely wide dynamic range of the design allows measurement of loads ranging from 0.1W to 2000W.

Conceptually, the instrument is quite straightforward (*Figure 1*). The device to be monitored is plugged into a standard 110V AC outlet which is mounted on the front panel of the instrument. The AC line voltage across the monitored load is divided down and fed via an op amp to one input of a 4-quadrant analog multiplier. The current through the load is determined by the voltage across a low resistance shunt. Even at 20A the shunt "steals" only 133 mV, eliminating the inaccuracies a high resistance current shunt would contribute. This single shunt is used for all ranges, eliminating the need to switch in high impedance shunts to obtain adequate signal levels on the high sensitivity scales.

This provision is made possible by low uncertainty in the current amplifier, whose output feeds the other multiplier

input. Switchable gain at the current amplifier allows decade setting of instrument sensitivity. The instantaneous power product ($E \times I$) drawn by the load is represented by the multiplier output. Because the multiplier is a 4-quadrant type, its output will be a true reflection of load power consumption, regardless of the phase relationship between voltage and current in the load. Because the multiplier and its associated amplifiers are connected directly to the AC line, they must be driven from a floating power supply. In addition, their outputs cannot be safely monitored with grounded test equipment, such as strip chart recorders. For this reason, the multiplier output drives an isolation amplifier which operates at unity gain but has no galvanic connection between its input and output terminals.

This feature is accomplished through pulse amplitude modulation techniques in conjunction with a small transformer, which provides isolation. The isolated amplifier output is ground referenced and may safely be connected to any piece of test equipment. This output is filtered to provide a strip chart output and drive the readout meter, both of which indicate load power consumption. The isolation amplifier output also biases a voltage-to-frequency converter which combines with digital counters to form a digital integrator. This allows power over time (watt-hours) to be integrated and displayed. Varying the divide ratio of the counters produces ranging of the watt-hour function.

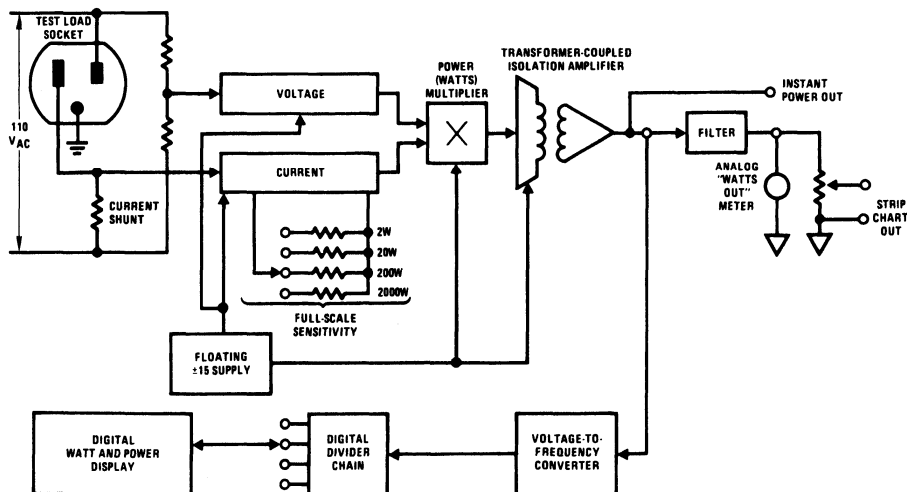
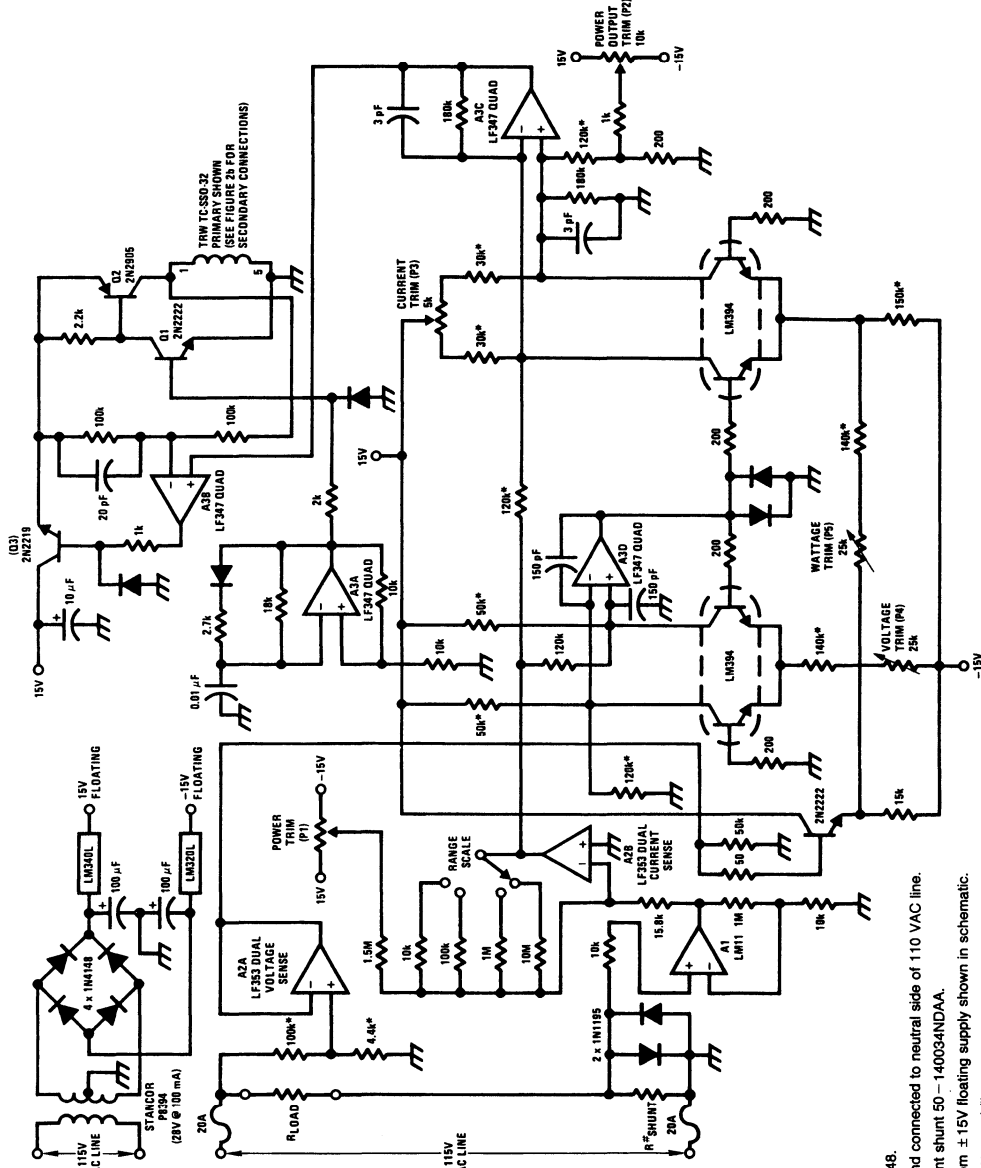


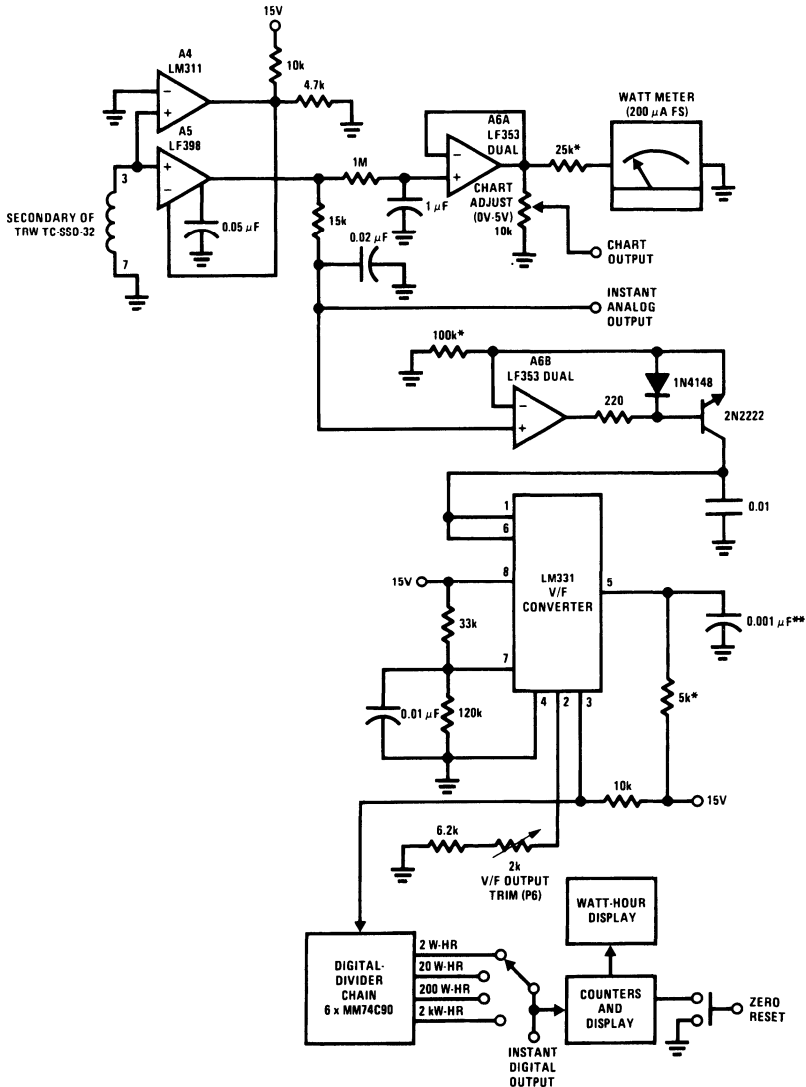
FIGURE 1

TL/H/6626-1



- Note 1: All diodes 1N4148.
- Note 2: ϕ floating ground connected to neutral side of 110 VAC line.
- Note 3: R# = G.E. current shunt 50 - 140034NDAA.
- Note 4: Circuit power from $\pm 15V$ floating supply shown in schematic.
- Note 5: *Resistors are 1% metal film types.

FIGURE 2a. Floating Half of Circuit is Connected Directly to the AC Line. Always Use Caution when Working with this Circuitry.



TL/H/5626-3

Note 1: *Resistors are 1% metal film types.

Note 2: **Polystyrene capacitor.

Note 3: DO NOT connect (ψ) ground of this half of circuit to (μ) ground of Figure 2a.

Note 4: ±15V power must come from a source other than floating supply of Figure 2a.

Note 5: Figure 2a and Figure 2b must be electrically isolated from each other.

FIGURE 2b. Grounded Side of Circuit. This Circuit Can Safely Be Connected to a Chart Recorder or Computer Due to Isolation Provided by TRW Transformer.

Figures 2a and 2b show the detailed schematic, with Figure 3 giving the waveforms of operation. The AC line is divided down by the 100 kΩ—4.4 kΩ resistor string. ½ of A2 (amplifier A) serves as a buffer and feeds one input of an analog multiplier configuration. A1 monitors the voltage across the current shunt at a fixed gain of 100. The other half of A2 (B) provides additional gain and calibrated switching of wattage sensitivities from 2W to 2000W full-scale over four decade

ranges. The 1N1195 diodes and the 20A fuses protect A1 and the shunt in the event a short appears across the load test socket. The voltage and current signals are multiplied by a multiplier configuration comprised of amplifiers A3, C and D, and the LM394 dual transistors. The multiplier is of the variable transconductance type and works by using one input to vary the gain of an amplifier whose output is the other input of the multiplier.

The output of the multiplier (*Figure 3*, Trace A) represents the instantaneous power consumed by the load. This information is used to bias a pulse amplitude modulating isolation amplifier. The isolation amplifier is made up of A3 (A and B) and the discrete transistors. The A3 (A) oscillator output (*Figure 3*, Trace B) biases the Q1-Q2 switch, which drives a pulse transformer. A3 (B) measures the amplitude of the pulses at the transformer and servo controls them to be the same amplitude as its "+" input, which is biased from the multiplier output. Q3 provides current drive capability and completes the feedback path for A3 (B). *Figure 3*, Trace D shows the pulses applied to the transformer. Note that the amplitude of the pulses applied to the transformer forms an envelope whose amplitude equals the multiplier output. *Figure 3*, Trace C shows Q3's emitter voltage changing to meet the requirements of the servo loop.

The amplitude modulated pulses appear at the transformer's secondary, which is referenced to instrument ground. The amplitude of each pulse is sampled by A5, a sample-and-hold amplifier. The sample command is generated by A4. The output of A5 is lightly filtered by the $15\text{ k}\Omega - 0.02\text{ }\mu\text{F}$ combination and represents a sampled version of the instantaneous power consumed in the load (*Figure 3*, Trace E). Heavy filtering by the $1\text{ M}\Omega - 1\text{ }\mu\text{F}$ time constant produces a smoothed version of the power signal, which drives the watts meter and the strip chart output via the A6 (A) buffer. The watt-hour time integration function is provided by an LM331 voltage-to-frequency converter and a digital divider chain which form a digital integrator. The lightly filtered A5 output is fed to A6 (B) which is used to bias the V/F converter. The V/F output drives a divider chain. The ratio of the divider chain sets the time constant of the integrator and is used to switch the scale factor of the watt-hours display. The additional counters and display provide the digital readout in watt-hours. A zero reset button allows display reset.

INSTRUMENT CALIBRATION

To calibrate the instrument, pull the 20A fuses from their holders. Next, adjust P1 for 0.00V out at A2 (B) with the watts range switch in the 2 watt position. Then, disconnect both multiplier input lines and connect them to floating ("H") instrument ground. Adjust P2 for 0V out at A6 (A). Next, apply a 10 Vp-p 60 Hz waveform to the current input of the multiplier (leave the voltage input grounded) and adjust P3 for zero volts out at A6 (A). Then, reverse the state of the multiplier inputs and adjust P4 for zero volts out at A6 (A). Reconnect the multiplier input into the circuit. Read the AC line voltage with a digital voltmeter. Plug in a known load (e.g., 1% power resistor) to the test socket and adjust P5 until the meter reads what the wattage should be (wattage = line voltage²/resistance of load). Finally, lift A6's (B's) "+" input line, apply 5.00V to it, and adjust P6 until the LM331V/F output (pin 3) runs at 27.77 kHz. Reconnect A6's (B's) input. This completes the calibration.

APPLICATIONS

Once calibrated, the watt-watt-hour meter provides a powerful measurement capability. A few simple tests provide some surprising and enlightening results. The strip chart of *Figure 4a* shows the measured power a home refrigerator draws over 3½ hours at a temperature set-point of 7°C. Each time the compressor comes on, the unit draws about 260W. Actually, the strip chart clearly shows that as the compressor warms up over time, the amount of power drawn drops off a bit. The watt-hour display was used to record the total watt-hours consumed during this 3½ hour period. The data is summarized in the table provided. With the temperature control in the refrigerator set to maintain 5°C, just 2°C colder, it can be seen that the compressor duty cycle shifts appreciably (*Figure 4b*), over 6%! This factor is directly reflected in the kW-H/cycle and yearly operating cost columns. If you want your milk 2°C colder you will have to pay for it!

HORIZONTAL = 2 ms/DIV

A = 5V/DIV
B = 50V/DIV
C = 5V/DIV
D = 10V/DIV
E = 10V/DIV

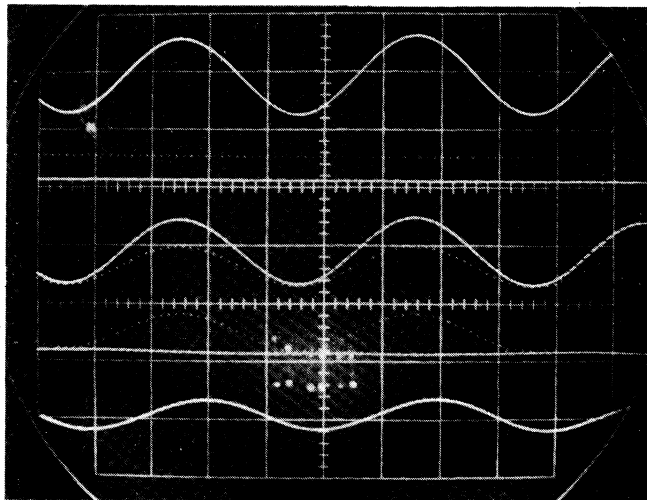
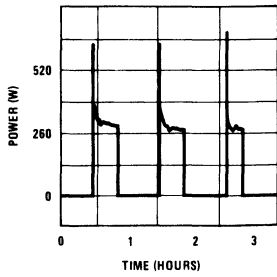


FIGURE 3

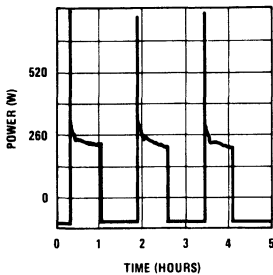
TL/H/5626-4



TL/H/5626-5

Temperature	Watts	Kilowatt-Hours/Cycle	Cost/Day	Cost/Year
5°C	260	0.119	\$0.1147	\$41.89
7°C	260	0.104	\$0.0998	\$36.44

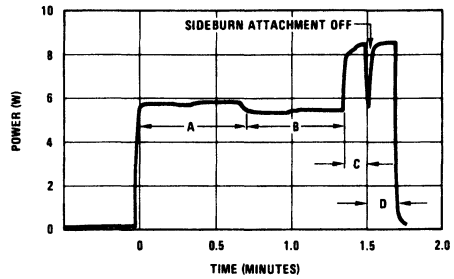
FIGURE 4a. Temperature = 7.0°C
Compressor Duty Cycle = 40%



TL/H/5626-6

FIGURE 4b. Temperature = 5.0°C
Compressor Duty Cycle = 46%

The strip chart of *Figure 5* is somewhat less depressing but no less informative. In this example, the watt-watt-hour meter was used to record power consumption during morning shaving with an electric razor. From the strip chart and the table it can be seen that various facial areas cost more to shave than others. The high power drawn by the sideburn attachment on the razor is somewhat compensated for by the relatively short period of time it is in use. A complete shave, including the 4 areas listed, costs 0.00692 cents/day or 8.68 cents per year. If this is too high, you can economize by growing a beard.



TL/H/5626-7

Facial Area	Power (W)	Watt-Hours	Cost (at 4¢ Kilowatt-Hours) Per Shave
Cheeks ("A")	5.8	0.173	0.00692¢
Upper/Lower Lip ("B")	5.4	0.123	0.00492¢
Right Sideburn ("C")	8.4	0.063	0.00252¢
Left Sideburn ("D")	8.4	0.061	0.00244¢

FIGURE 5

Circuit Applications of Sample-Hold Amplifiers

National Semiconductor
Application Note 266



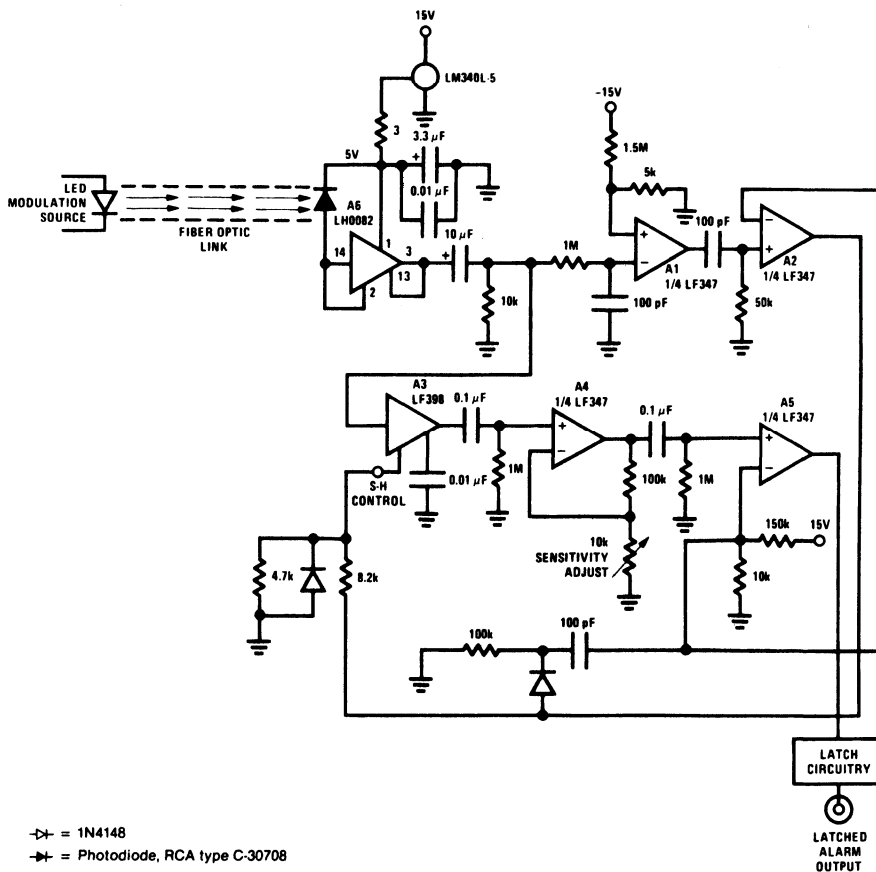
AN-266

Most designers are familiar with the sample-and-hold amplifier as a *system* component which is utilized in high speed data acquisition work. In these applications, the sample-and-hold amplifier is used to store analog data which is then digitized by a relatively slow A/D converter. In this fashion, high speed or multiplexed analog data can be digitized without resorting to complex and expensive ultra-high speed A/D converters.

The use of sample-and-hold amplifiers as *circuit* oriented components is not as common as the class of application described above. This is unfortunate, because sampling techniques allow circuit functions which are sophisticated, low cost and not easily achieved with other approaches. An excellent example is furnished by the fiber optic data link intrusion alarm of *Figure 1*.

Fiber Optic Data Link Intrusion Alarm

The circuit of *Figure 1* will detect an attempt to tap a fiber optic data link. It may be used with any fiber optic communication system which transmits data in pulse coded form. The circuit works by detecting any short-term change in the loss characteristics of the fiber optic line. Long term changes due to temperature and component aging do not affect the circuit. The amplitude of the pulses at the LH0082 fiber optic receiver IC (A6) will depend upon the characteristics of the photocomponents and the losses in the line. Any attempt to tap the fiber optic will necessitate removal of some amount of light energy. This will cause an instantaneous drop in the pulse amplitude at A6's output. The amplitude of each of A6's output pulses is sampled by the LF398 sample-and-hold amplifier (A3), A1 and A2 provide a delayed



TL/H/5627-1

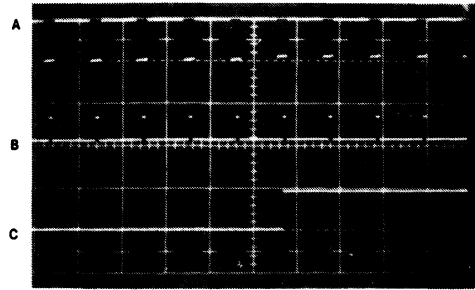
FIGURE 1. Fiber optic link eavesdropping attempts are immediately detected by this design. Working on a pulse-by-pulse comparison basis, A3 samples each input pulse and holds its output amplitude value at a DC level. Anything that disturbs the next input's amplitude causes a jump in this level; because A4 is an AC-coupled amplifier, the comparator and latch then activate.

sample-hold control pulse to A3, which insures that A6's output is sampled well after its output has settled. Under normal conditions, the pulse-to-pulse amplitude variations at A6's output will be negligible, and the output of A3 will be at a DC level. A4 is AC coupled and its output will be zero. During an intrusion attempt, energy will be removed from the line and A6's output will shift, causing A3 to jump to a new DC level. This shift will be AC amplified by A4 and the A5 comparator will trip, activating the latch circuitry.

Note that the circuit is not affected by slow drifts in circuit components over time and temperature because it is only sensitive to AC disturbances on the line. In addition, the frequency and pulse widths of the data may vary over wide ranges. The photo of *Figure 2* shows the circuit in operation. Trace A is A6's output. Trace B is the sample-hold control pin at A3 and Trace C is the latch-alarm output. In this figure, a disturbance on the fiber optic line has occurred just past the midpoint of the photo. This is reflected by the reduced amplitude of A6's output at this point. The latch-alarm output goes high just after the sample command rises, due to the sample-hold amplifier jumping to the new value at A6's output. In the photo, the disturbance has been made large ($\approx 10\%$) for viewing purposes. In practice, the circuit will detect an energy removal as small as 0.1% from the line.

Proportional Pulse Stretcher

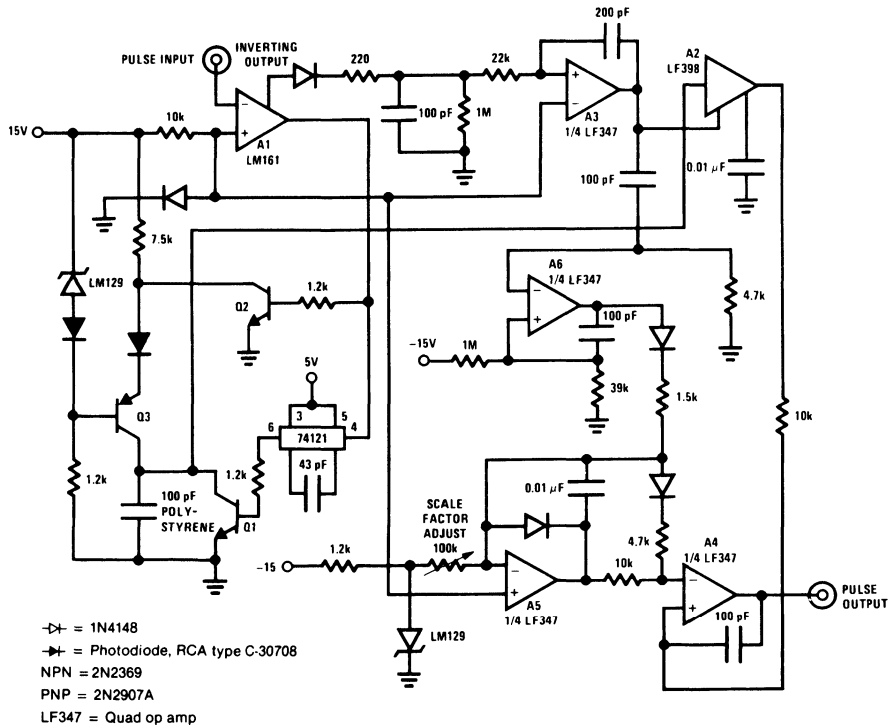
The circuit of *Figure 3* allows high accuracy measurement of short width pulse durations. The pulses may be either



TL/H/5627-2

TRACE	VERTICAL	HORIZONTAL
A	10V/DIV	1 mSEC/DIV
B	10V/DIV	1 mSEC/DIV
C	10V/DIV	1 mSEC/DIV

FIGURE 2. An intrusion attempt occurring just past the midpoint of Trace A is immediately detected by *Figure 1's* circuit. The photodetector's amplifier output (A) shows a slight amplitude drop. The next time the S-H amplifier samples this signal (B), the alarm latch sets (C).



TL/H/5627-3

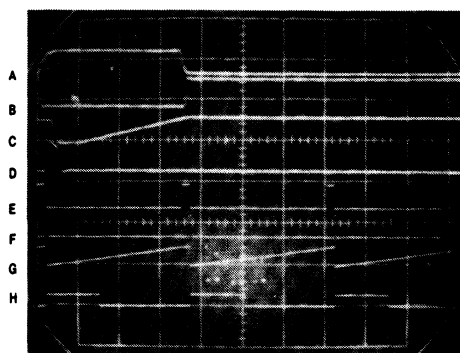
FIGURE 3. Pulse width measurement accuracy is enhanced by this pulse stretching circuit. A short input pulse triggers the 74121 one-shot and (via Q1) discharges the 100 pF capacitor while concurrently turning on the recharging current source, Q3. So long as the input pulse is present, the capacitor charges; when the pulse ends, the capacitor's voltage is proportional to the pulse's width. S-H amplifier A2 samples this voltage, and the resultant DC level controls the ON duration of the A4/A5 pulse width modulator.

repetitive or single-shot events. Using digital techniques, a 1% width measurement of a 1 μ s event requires a 100 MHz clock. This circuit gets around this requirement by linearly amplifying the width of the input pulse with a time multiplying factor of 1000 or more. Thus, a 1 μ s input event will yield a 1 ms output pulse which is easy to measure to 1%. This measurement capability is useful in high energy physics and nuclear instrumentation work, where short pulse width signals are common.

Figure 4, Trace A shows a 350 ns input pulse applied to the circuit of Figure 3. The A1 comparator output goes low (Figure 4, Trace B), triggering the DM74121 one shot, which resets the 100 pF capacitor to 0V via Q1 with a 50 ns pulse (Trace C). Concurrently, Q2 is turned off, allowing the A3 current source to charge the 100 pF capacitor in a linear fashion (Figure 4, Trace C). This charging continues until the circuit input pulse ends, causing A1's output to return high and cutting off the current source. The voltage across the 100 pF capacitor at this point in time is directly proportional to the width of the circuit input pulse. This voltage is sampled by the LF398 sample-hold amplifier (A2) which re-

ceives its sample-hold command from A3 (Figure 4, Trace E)—note horizontal scale change at this point). A3 is fed from a delay network which is driven by A1's inverting output. The output of A2 is a DC voltage, which represents the width of the most recently applied pulse to the circuit's input. This DC potential is applied to A4, which along with A5 comprises a voltage controlled pulse width modulator. A5 ramps positive (Figure 4, Trace G) until it is reset by a pulse from A6, which goes high for a short period (Figure 4, Trace F) each time A3's output (Figure 4, Trace E) goes low. The ramps at A6's output are compared to A2's output voltage by A4, which goes high for a period linearly dependent on A2's output value (Figure 4, Trace H). This pulse is the circuit's output.

In this particular circuit, the time amplification factor is about 2000 with a 1 μ s full-scale width giving a 1.4 ms output pulse. Absolute accuracy of the time expansion is 1% (10 ns) referred to input with resolution down to 2 ns. The 50 ns DM74121 reset pulse limits the minimum pulse width the circuit can measure.



TL/H/5627-4

TRACE	VERTICAL	HORIZONTAL
A	10V/DIV	100 nSEC/DIV
B	5V/DIV	100 nSEC/DIV
C	5V/DIV	100 nSEC/DIV
D	5V/DIV	100 nSEC/DIV
E	50V/DIV	500 μ SEC/DIV
F	50V/DIV	500 μ SEC/DIV
G	20V/DIV	500 μ SEC/DIV
H	100V/DIV	500 μ SEC/DIV

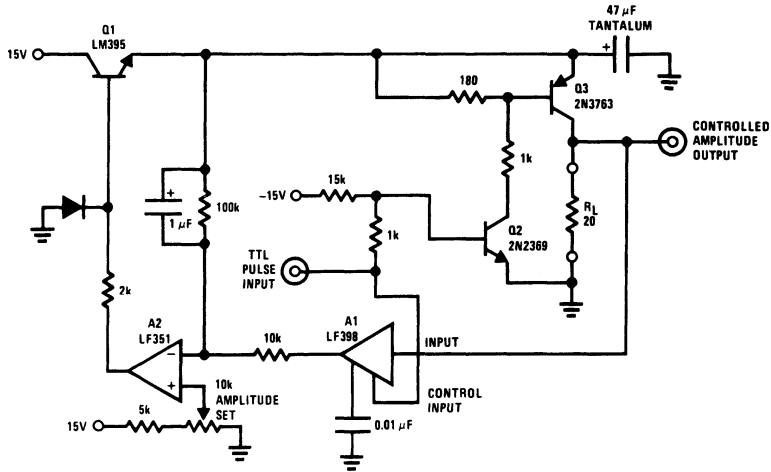
FIGURE 4. A sequence of events in Figure 3's circuit stretches a 350 ns input pulse (A) by a factor of 2000. When triggered, comparator A1 goes low (B). This action starts the recharging of a capacitor (C) after its previously stored charge has been dumped (D). When the input pulse ends, the capacitor's voltage is sampled under control of a delayed pulse (E) derived from the input amplifier's inverting output (F). The sampled and held voltage then turns off a voltage controlled pulse width modulator (G), and a stretched output pulse results (H).

Controlled Amplitude Pulser

Figure 5 depicts a circuit which converts an input pulse train into an amplitude stabilized pulse output which will drive a 20Ω load. The output pulse amplitude is adjustable from 0V to 10V and is stable over time, temperature and load changes. This circuit function is useful in automatic test equipment and general laboratory applications.

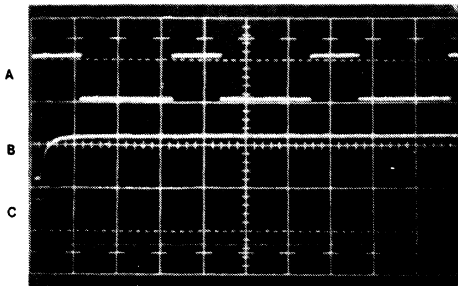
The circuit works by storing the sampled amplitude of the output pulse as a DC level, and supplying this information to a feedback loop which controls the voltage applied to the output switch. Each time a pulse is applied at the circuit input, the Q2-Q3 combination turns on and drives the load.

Simultaneously, the A1 sample-and-hold amplifier is placed in the sample mode. When the pulse ends, A1's output is at a DC level equal to the amplitude of the output pulse. This level is compared to the amplitude set DC reference by A2, whose output drives Q1. Q1's emitter provides the DC supply level to the Q2-Q3 switch. This servo action forces the amplitude of the output pulse to be the same as the DC potential at the amplitude set potentiometer wiper, regardless of Q3 switch losses or loading. In Figure 6, Trace A is the circuit output. Traces B and C detail the rising and falling edges of the output (note horizontal sweep time change for B and C) with clean 50 ns transitions into the 20Ω load.



TL/H/5627-5

FIGURE 5. Pulse amplitude control results when this circuit samples an output pulse's amplitude and compares it with a preset reference level. When the output exceeds this reference, A2 readjusts switching transistor Q3's supply voltage to the correct level.



TRACE	VERTICAL	HORIZONTAL
A	10V/DIV	1 mSEC/DIV
B	10V/DIV	100 nSEC/DIV
C	10V/DIV	100 nSEC/DIV

TL/H/5627-6

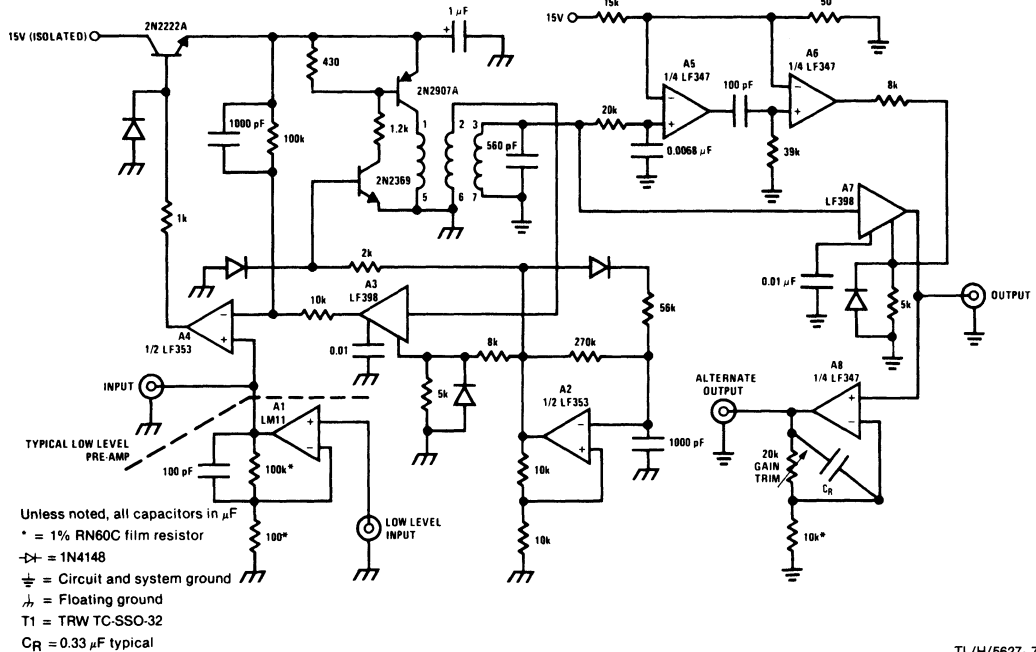
FIGURE 6. A 10V, 0.5A pulse (A) is amplitude stabilized by the S-H technique depicted in Figure 5. Note the clean 50 ns rise (B) and fall (C) times.

Isolated Input Signal Conditioning Amplifier

Figure 7 is a logical and very powerful extension of the controlled amplitude pulser shown in Figure 5. This circuit permits measurement of a small amplitude signal, e.g., thermocouples, in the presence of common-mode noise or voltages as high as 500V. This is a common requirement in industrial control systems. Despite the fact that the input terminals are fully galvanically isolated from the output, a transfer accuracy of 0.1% may be expected. With the optional low-level pre-amplifier shown, inputs as low as 10 mV full-scale may be measured.

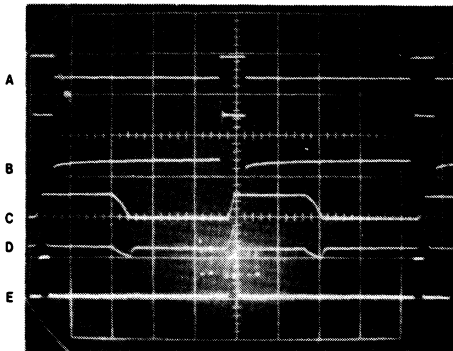
The circuit works by converting the input signal into a pulse train whose amplitude is linearly dependent on the input

signal value. This pulse train drives a transformer which provides total galvanic isolation of the input circuitry from ground. The transformer output is then demodulated back to a DC level to provide the circuit's system ground referenced output. The amplitude of the pulse train which drives the transformer is controlled by a loop very similar to the one described in Figure 5. The amplitude set potentiometer has been deleted, and the servo amplifier's "+" input becomes the circuit input. A1, a low drift X1000 amplifier, may be employed for boosting low-level inputs. The pulse train is supplied by A2, which is set up as an oscillator (A2 output shown in Figure 8, Trace A). The feedback to the pulse amplitude stabilizing loop is taken from an isolated



TL/H/5627-7

FIGURE 7. Obtain input signal isolation using this circuit's dual S-H scheme. Analog input signals amplitude modulate a pulse train using a technique similar to that employed in Figure 5's design. This modulated data is transformer coupled, and thereby isolated, to a DC filter stage, where it is resampled and reconstructed.



TL/H/5627-8

FIGURE 8. Figure 7's in-circuit oscillator (A2) generates both the sampling pulse (A) and the switching transistor's drive. Modulated by the analog input signal, Q2's (and therefore T1's) output (B) is demodulated by S-H amplifier A7. A5's output (C) and A6's input (D) and output (E) provide a delayed sample command.

TRACE	VERTICAL	HORIZONTAL
A	50V/DIV	100 $\mu\text{SEC}/\text{DIV}$
B	1V/DIV	100 $\mu\text{SEC}/\text{DIV}$
C	50V/DIV	100 $\mu\text{SEC}/\text{DIV}$
D	10V/DIV	100 $\mu\text{SEC}/\text{DIV}$
E	5V/DIV	100 $\mu\text{SEC}/\text{DIV}$

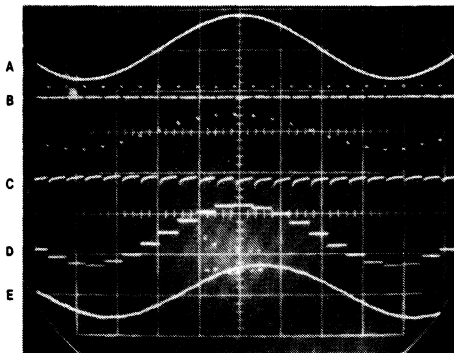
secondary of the transformer, which insures high accuracy amplitude information transfer. The amplitude coded information at the transformer's secondary (Figure 8, Trace B) is demodulated back to a DC level by sample-and-hold amplifier, A7. A5 (output, Figure 8, Trace C) and A6 ("+" input, Figure 8, Trace D; output, Figure 8, Trace E) provide a delayed sample command to A7, ensuring accurate acquisition of the transformer's output pulse amplitude. A8 provides gain trimming and filtering capability.

Figure 9 provides very graphic evidence of the circuit at work. Here, a DC biased sine wave (Figure 9, Trace A) is fed into the circuit input. Trace B is the clock from A2's output. Trace C is the transformer secondary (input of A7 sample-

hold amplifier) and Trace D is A7's output. Trace E shows the filter's output at A8.

Precision, High Efficiency Temperature Controller

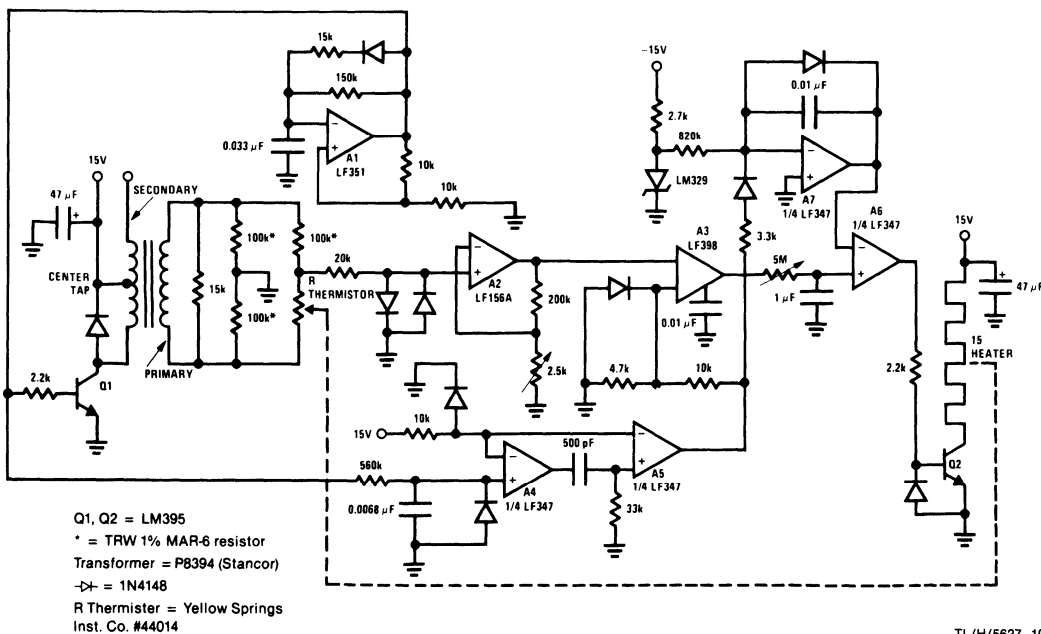
The sample-and-hold amplifier in Figure 10 is used to provide very high stability in an oven temperature control circuit. In this circuit, the output signal of the pulse driven thermistor-bridge is ten times greater than the usual DC driven bridge. In thermistor-bridges, power dissipation in the resistors and thermistor is the limiting factor in how much DC bridge drive may be used. However, if the bridge drive is applied in the form of high voltage pulses at very low duty cycle, average power dissipation will be low and a high bridge output signal will result.



TRACE	VERTICAL	HORIZONTAL
A	5V/DIV	100 mSEC/DIV
B	100V/DIV	
C	5V/DIV	
D	5V/DIV	
E	5V/DIV	

TL/H/5627-9

FIGURE 9. Completely input-to-output isolated, Figure 7's circuit's analog input signal (A) is sampled by a clock pulse (B) and converted to a pulse amplitude modulated format (C). After filtering and resampling, the reconstructed signal (D) is available smoothed (E).



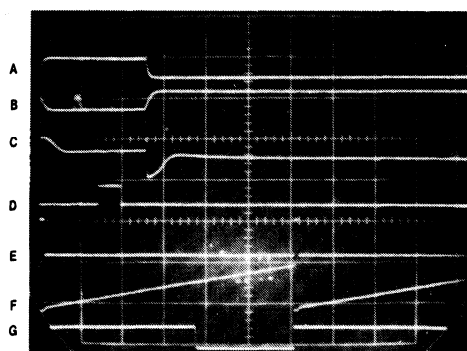
TL/H/5627-10

FIGURE 10. Tight temperature control results when high voltage pulses synchronously drive a thermistor-bridge—a trick that increases signal level—and are then sampled and used to control a pulse width modulated heater driver.

In *Figure 10*, this operation is implemented by having the A1 oscillator drive Q1 to energize a common 24V transformer used "backwards". The transformer's floated output is a 100V pulse which is applied directly across the thermistor-bridge. With one side of the bridge output grounded, the bridge drive with respect to ground appears as complementary 50V pulses (*Figure 11*, Traces A and B). A2 provides amplification of the bridge's pulsed output (*Figure 11*, Trace C). A3, a sample-and-hold amplifier, samples the middle of A2's output pulses and has a DC output equal to the amplitude of these pulses. Proper timing for A3's sample command (*Figure 11*, Trace D) is provided by the A4-A5 pair and their associated RC networks. The DC output of A3 is low-pass filtered and fed to A6, which combines with A7 to form a simple pulse width modulator. The output of A7 is a ramp (*Figure 11*, Trace F—note horizontal scale change) which is periodically reset by A5's output (*Figure 11*, Trace E). This ramp is compared at A6 to A3's output, and the resultant pulse at A6's output (*Figure 11*, Trace G) is used to drive the

Q2 heater control switch. In this fashion, the ON time of the pulse applied to the heater will be proportional to the sensed offset at the thermistor-bridge. Thermal feedback from the heater to the thermistor completes a loop around the circuit. The 5 M Ω potentiometer is used to adjust the time constant of this loop, and the 2.5k potentiometer at A2 sets the gain.

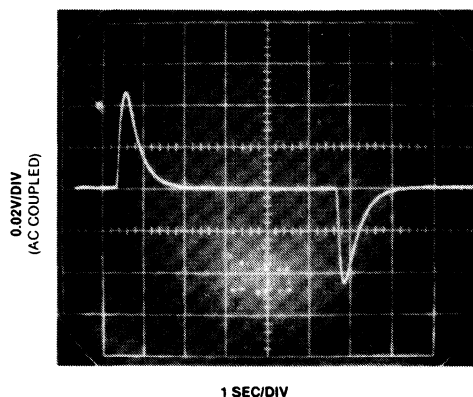
In operation, with the thermistor and heater tightly coupled, the time constant of the loop is adjusted by applying small step changes in the temperature setpoint. This is done by alternately opening and closing a switch across a 100 Ω resistor in series with one of the bridge resistors. For the thermistor shown, this represents a 0.02°C step. The response of the loop to these steps can be monitored at A3's output. With the loop time constant and gain properly adjusted, A3's output will settle in a minimum amount of time in response to the steps. *Figure 12* shows settling for both "+" and "-" steps, with settling inside 2 seconds for either polarity step.



TL/H/5627-11

FIGURE 11. Driving a thermistor-bridge with complementary high voltage pulses (A and B) permits high gain amplification without drift problems (C). Driven by a delayed sample command (D), a S-H amplifier converts the bridge's error signal to a DC level (E) that controls a pulse width modulated heater driver (F and G).

TRACE	VERTICAL	HORIZONTAL
A	100V/DIV	200 μ SEC/DIV
B	100V/DIV	200 μ SEC/DIV
C	5V/DIV	200 μ SEC/DIV
D	10V/DIV	200 μ SEC/DIV
E	5V/DIV	1 mSEC/DIV
F	10V/DIV	1 mSEC/DIV
G	50V/DIV	1 mSEC/DIV



TL/H/5627-12

FIGURE 12. Tight heater to thermistor coupling and careful calibration can provide rapid temperature restabilization. Here the controlled oven recovers within 2 seconds after $\pm 0.002^\circ\text{C}$ steps.

Once adjusted, and driving a well insulated and designed oven, the circuit's control stability can be monitored. The high output signal levels from the bridge, in combination with the gain provided by A2, yield extremely good performance.

Sample-Hold Amplifier Terms

Acquisition Time: The time required to acquire a new analog input voltage with an output step of 10V. Note that acquisition time is not just the time required for the output to settle, but also includes the time required for all internal nodes to settle so that the output assumes the proper value when switched to the hold mode.

Aperture Time: The delay required between hold command and an input analog transition, so that the transition does not affect the held output.

Dynamic Sampling Error: The error introduced into the held output due to a changing analog input at the time the hold command is given. Error is expressed in mV with a given hold capacitor value and input slew rate. Note that this error term occurs even for long sample times.

Gain Error: The ratio of output voltage swing to input voltage swing in the sample mode expressed as a percent difference.

Hold Settling Time: The time required for the output to settle within 1 mV of final value after the hold logic command.

Hold Step: The voltage step at the output of the sample-hold when switching from sample mode to hold mode with a steady (DC) analog input voltage. Logic swing is specified, usually 5V.

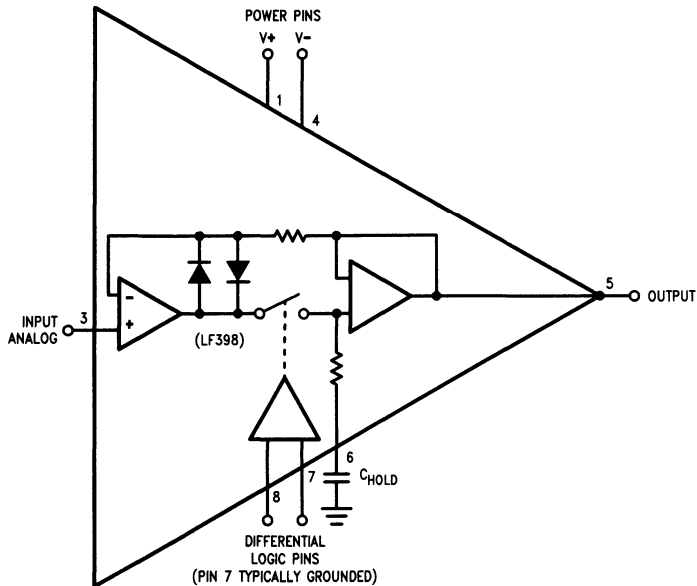


FIGURE 13. Typical Sample-Hold IC Amplifier

TL/H/5627-13

Circuit Applications of Multiplying CMOS D to A Converters

National Semiconductor
Application Note 269

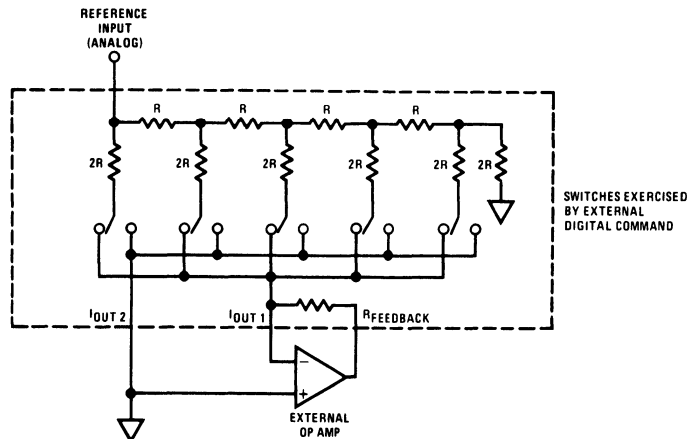


AN-269

The 4-quadrant multiplying CMOS D to A converter (DAC) is among the most useful components available to the circuit designer. Because CMOS DACs allow a digital word to operate on an analog input, or vice versa, the output can represent a sophisticated function. Unlike most DAC units, CMOS types permit true bipolar analog signals to be applied to the reference input of the DAC (see shaded area for CMOS DAC details).

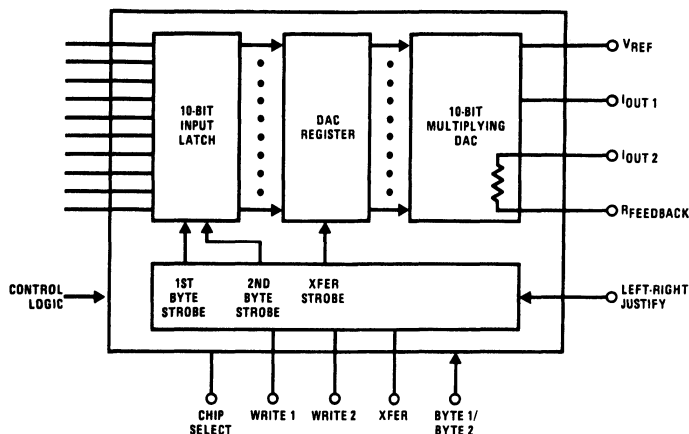
This feature is one of the keys to the CMOS DAC's versatility. Although D to A converters are usually thought of as system data converters, they can also be used as circuit elements to achieve complex functions. Some CMOS

DACs contain internal logic which makes interface with microprocessors and digital systems easy. In circuit oriented applications, however, the "bare bones" DACs will usually suffice. As an example, *Figure 1* shows a 0 kHz–30 kHz variable frequency sine wave generator which has essentially instantaneous response to digital commands to change frequency. This capability is valuable in automatic test equipment and instrumentation applications and is not readily achievable with normal sine wave generation techniques. The linearity of output frequency to digital code input is within 0.1% for each of the 1024 discrete output frequencies the 10-bit DAC can generate.



Details (Simplified) of CMOS DAC1020—Last 5 Bits Shown

Other CMOS DACs are similar in the nature of operation but also include internal logic for ease of interface to microprocessor based systems. Typical is the DAC1000 shown below.



TL/H/5628-1

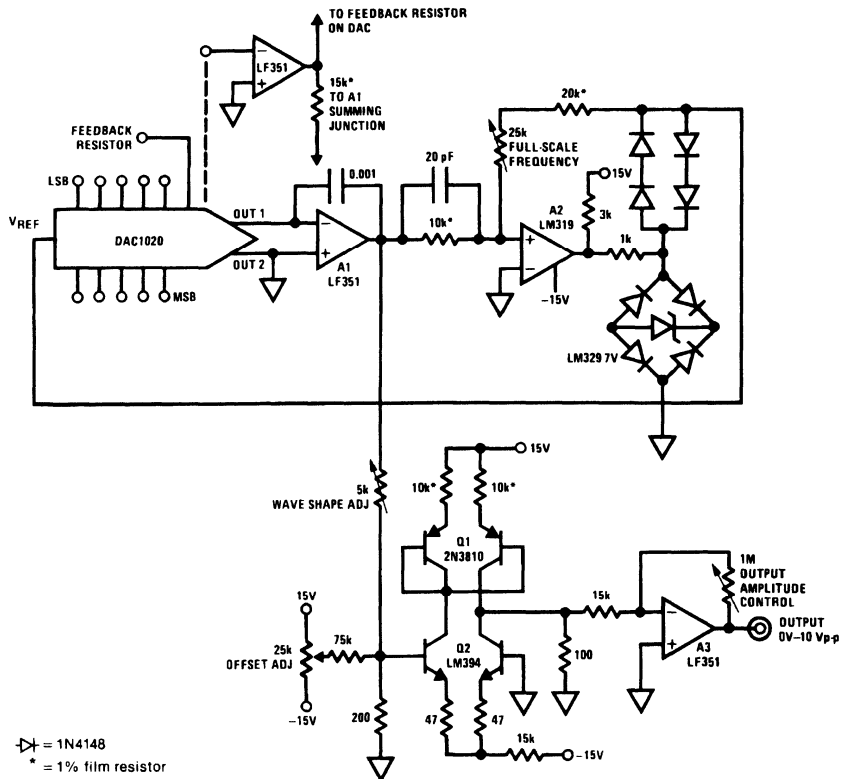


FIGURE 1

TL/H/5628-2

To understand this circuit, assume A2's output is negative. This means that its zener bounded output applies $-7V$ to the DAC's reference input. Under these conditions, the DAC pulls a current from A1's summing junction which is directly proportional to the digital code applied to the DAC. A1, an integrator, responds by ramping in the positive direction. When A1 ramps far enough so that the potential at A2's "+" input just goes positive, A2's output changes state and the potential at the DAC's reference input becomes $+7V$. The DAC output current reverses and the A1 integrator is forced to move in the negative direction. When the negative-going output of A1 becomes large enough to pull A2's "+" input slightly, negative A2's output changes state and the process repeats. The resultant amplitude stabilized triangle wave at A1's output will have a frequency which is dependent on the digital word at the DAC. The 20 pF capacitor provides a slight leading response at high operating frequencies to offset the 80 ns response time of A2, aiding overall circuit linearity. The triangle wave is applied to the Q1-Q2 shaper network, which furnishes a sine wave output. The shaper works by utilizing the well known logarithmic relationship between V_{BE} and collector current in a transistor to smooth the triangle wave.

To adjust this circuit, set all DAC digital inputs high and trim the 25k pot for 30 kHz output. Next, connect a distortion analyzer to the circuit output and adjust the 5k and 75k potentiometers associated with the shaper network for minimum distortion. The output amplifier may be adjusted with its potentiometer to provide the desired output amplitude.

This circuit permits rapid switching of output frequency which is not possible with other methods. Figure 2 shows the clean, almost instantaneous response when the digital word is changed. Note that the output frequency shifts immediately by more than an order of magnitude with no untoward dynamics or delays. If operation over temperature is required, the absolute change in resistance in the DAC's internal ladder network may cause unacceptable errors. This can be corrected by reversing A2's inputs and inserting an amplifier (dashed lines in schematic) between the DAC and A1. Because this amplifier uses the DAC's internal feedback resistor, the temperature error in the ladder is cancelled and more stable operation results.

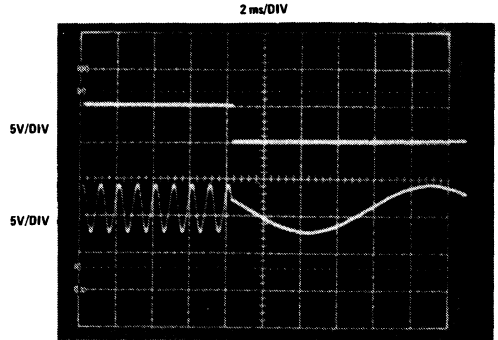


FIGURE 2

TL/H/5628-3

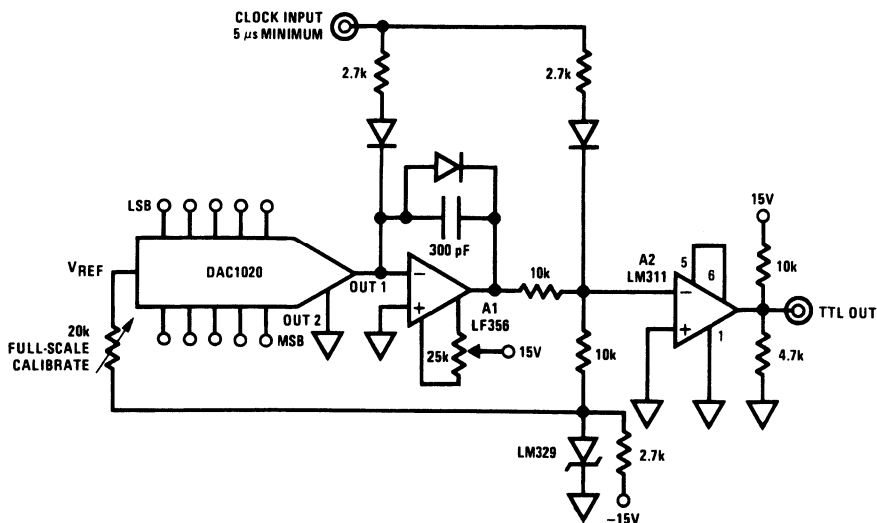


FIGURE 3

TL/H/5628-4

Digitally Programmable Pulse Width Modulator

The circuit of *Figure 3* allows the DAC inputs to control a pulse width. This capability has been used in automatic testing of secondary breakdown limits in switching transistors. The high resolution of control the DAC exercises over the pulse width is useful anywhere wide range, precision pulse width modulation is necessary. In this circuit, the length of time the A1 integrator requires to charge to a reference level is determined by the current coming out of the DAC. The DAC output current is directly proportional to the digital input code. Both the DAC analog input and the reference trip point are derived from the LM329 voltage reference. During the time the integrator output (*Figure 4*, Trace A) is below the trip point, the A2 comparator output remains high (*Figure 4*, Trace B). When the trip point is exceeded, A2's output goes low. In this fashion, the DAC input code can vary the output pulse width over a range determined by the DAC resolution. Traces C, D and E show the fine detail of the resetting sequence (note expanded horizontal scale for these traces). Trace C is the 5 μ s clock pulse. When this pulse rises, the A1 integrator output (Trace D) is forced neg-

ative until it bounds against the diode in its feedback loop. During the time the clock pulse is high, the current through the 2.7k diode path forces A2's output low. When the clock pulse goes low, A2's output goes high and remains high until the A1 integrator output amplitude exceeds the trip point. To calibrate this circuit set all DAC bits high and adjust the "full-scale calibrate" potentiometer for the desired full-scale pulse width. Next, set only the DAC LSB high and adjust the A1 offset potentiometer for the appropriate length pulse, e.g., 1/1024 of the full-scale value for a 10-bit DAC. If the 2.2mV/ $^{\circ}$ C drift of the clamp diode in A1's feedback loop is objectionable it can be replaced with an FET switch.

Digitally Controlled Scale Factor Logarithmic Amplifier

Wide dynamic measurement range is required in many applications, such as photometry. Logarithmic amplifiers are commonly employed in these applications to achieve wide measurement range. In such applications it is often required to be able to set the scale factor of the logarithmic amplifier. A DAC controlled circuit permits this to be done under digital control. *Figure 5* shows a typical logarithmic amplifier circuit. Q1 is the actual logarithmic converter transistor, while Q2 and the 1 k Ω resistor provide temperature compensation. The logarithmic amplifier output is taken at A3. The digital code applied to the DAC will determine the overall scale factor of the input voltage (or current) to output voltage ratio.

Digitally Programmable Gain Amplifier

Figure 6 shows how a CMOS DAC can be used to form a digitally programmable amplifier which will handle bipolar input signals. In this circuit, the input is applied to the amplifier via the DAC's feedback resistor. The digital code selected at the DAC determines the ratio between the fixed DAC feedback resistor and the impedance the DAC ladder presents to the op amp feedback path. If no digital code (all zeros) is applied to the DAC, there will be no feedback and the amplifier output will saturate. If this condition is objectionable, a large value (e.g. 22 M Ω) resistor can be shunted across the DAC feedback path with minimal effect at lower gains. It is worth noting that the gain accuracy of this circuit is directly dependent on the open loop gain of the amplifier employed.

TRACES A AND B = 500 μ s/DIV
TRACES C, D AND E = 1 μ s/DIV

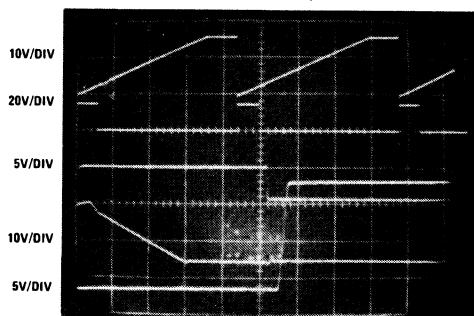
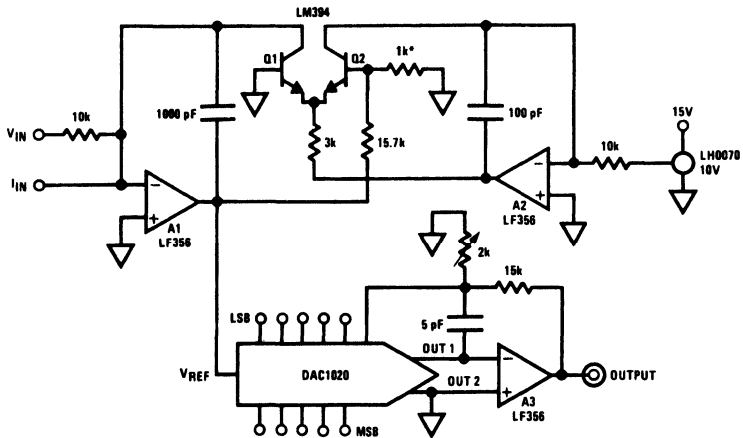


FIGURE 4

TL/H/5628-5



*Tel-Labs Q-81

FIGURE 5

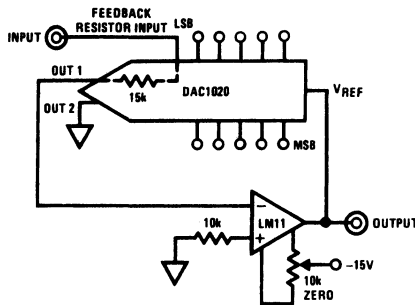


FIGURE 6

TL/H/5628-7

Digitally Controlled Filter

In *Figure 7* the DAC is used to control the cutoff frequency of a filter. The equation given in the figure governs the cutoff frequency of the circuit. In this circuit, the DAC allows high resolution digital control of frequency response by effectively varying the time constant of the A3 integrator. *Figure 8* dramatically demonstrates this. Here, the circuit is driven from the test circuit shown in *Figure 7*.

As each input square wave is presented to the filter the one-of-ten decoder sequentially shifts a "one" to the next DAC digital input line. Trace A is the input waveform, while Trace B is the waveform at A1's output (the reference input of the DAC). The circuit output at A3 appears as Trace C. It is clearly evident that as the decoder shifts the "one" towards the lower order DAC inputs the circuit's cutoff frequency decays rapidly.

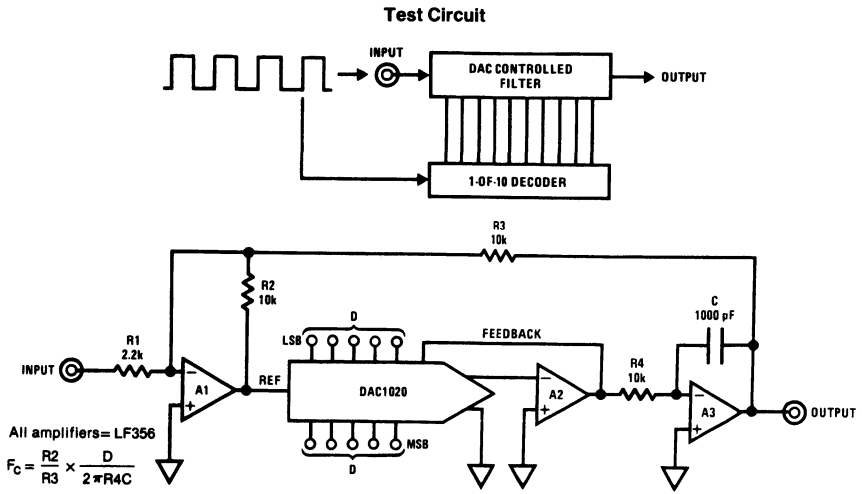


FIGURE 7

TL/H/5628-8

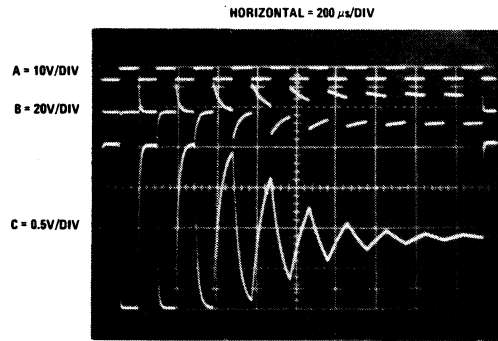


FIGURE 8

TL/H/5628-9

Applying the New CMOS MICRO-DAC™

National Semiconductor
Application Note 271
Tim Regan



Most microprocessor based systems designers will find that the new CMOS MICRO-DAC are among the most interesting and versatile devices they will include in their system. The availability of these devices opens a vast new area of applications where the microprocessor can provide an intelligent controlling function in the analog world. Traditional analog control devices, primarily potentiometers and switches which require a time-consuming and often erroneous human interface, can often be replaced by a processor and DACs to perform precise and automatic controls. A little creative thinking can easily generate several functions that could be better performed automatically. The purpose of this note is to stimulate this thought and to illustrate the versatility of CMOS DACs to achieve results.

The use of CMOS processing in the fabrication of the MICRO-DAC offers several important features. The primary advantage is that the current switching R-2R ladder network, used for the actual D to A conversion, can conduct current in both directions (sourcing or sinking current at its analog output) to control either a positive or negative fixed voltage reference or an AC signal. In addition, all of the necessary digital input conditioning circuitry to permit a direct microprocessor interface with no additional logic devices needed is included with minimal device power requirements. All of the MICRO-DAC can be controlled from an 8-bit data bus regardless of the number of digital inputs for a particular device. The operation of the R-2R ladder and the digital interface signal requirements are explained in detail on the actual device data sheets.

Resolution and linearity are the most important characteristics of the analog output of any D to A. Linearity is important to insure that each and every analog output quantity is predictable within a given tolerance (specified as a percent of the full-scale range) for any applied digital word. Resolution defines the number of possible analog output quantities available within a given range. Higher resolution in a DAC serves to minimize the gaps in the analog output inherent in digitally-based controls. The new line of MICRO-DAC offers a wide variety of converters to fit the accuracy and resolution requirements of a great number of applications. The device part numbers are summarized in *Figure 1*.

In the application circuits that follow, the connections for the control pins for the actual digital interface are omitted for simplicity. Several methods of configuring the DAC to accept its inputs from a processor exist and are described on the data sheets. The actual method used depends on the overall system provisions and requirements. The digital input code is referred to as D and represents the decimal equivalent of the binary input. For example, D would range from 0 to 4095 in steps of 1 to describe the full range of digital inputs for a 12-bit MICRO-DAC. Any of the MICRO-DAC can be used in any of the circuits shown, depending on accuracy and/or resolution requirements.

THE DIGITAL POTENTIOMETER

The most common and basic application of a DAC is generating discrete voltage output levels within a given span, and serving in essence as an attenuator (*Figure 2*). The applied digital input word multiplies the applied reference voltage, and the output voltage is this product normalized to the DAC's resolution. The op amp shown is used to convert the output current from the DAC to a voltage via a feedback resistor included in the DAC (R_{FB}). This output current ranges from a near zero output leakage (on the order of 10 nA) for an applied code of all zeros ($D = 0$), to a full-scale value ($D = 2^n - 1$, where n is the DAC's bits of resolution) of V_{REF} divided by the R value of the internal R-2R ladder network (nominally 15 k Ω). The current at $I_{OUT 2}$ is equal to that caused by the one's complement of the applied digital input, so while $I_{OUT 1}$ is at full-scale, $I_{OUT 2}$ will be zero. Note that the output voltage is the opposite polarity of the applied reference voltage, but since CMOS DACs can accept bipolar reference voltages, if a positive output is needed, a negative reference can be applied. To preserve the linearity of the output, the two current output pins of the DAC must be as close to 0V as possible, which requires the input offset voltage of the op amp to be nulled. The amount of linearity error degradation is approximately $V_{OS} \div V_{REF}$. For AC signal attenuation, in audio applications for example, the DAC's linearity over the full range of the applied reference voltage, even as it passes through zero, is sufficiently good enough to distort a 10V peak sine wave by only 0.004%.

Linearity Error (% of Full-Scale)	Resolution		
	8 Bits 256 Output Steps	10 Bits 1024 Output Steps	12 Bits 4096 Output Steps
±0.012%			DAC1208, DAC1230
±0.024%			DAC1209, DAC1231
±0.05%	DAC0830	DAC1000, DAC1006	DAC1210, DAC1232
±0.1%	DAC0831	DAC1001, DAC1007	
±0.2%	DAC0832	DAC1002, DAC1008	

FIGURE 1. The MICRO-DAC Family

The feedback capacitor shown in *Figure 2* is added to improve the settling time of the output as the input code is changed. With no compensation, a fair amount of overshoot and ringing appears at the output due to a feedback pole formed by the feedback resistor, and the output capacitance of the DAC, which appears from the (-) input of the op amp ground.

It is most desirable to select an op amp for use with the MICRO-DAC which combines good DC characteristics, primarily low V_{OS} and low V_{OS} drift, with fast AC characteristics such as slew rate, settling time and bandwidth. Such a combination is difficult to find in a single op amp for use with the higher accuracy 12-bit DACs. *Figure 3* shows an op amp configuration which combines the excellent DC input characteristics of the LM11 with the fast response of an LF351 BI-FET™ op amp.

The low cost, high resolution, and stability with time and temperature of the MICRO-DAC allow precise output levels that rival the capability of the best multiple turn potentiometers, and can automatically be adjusted, as required, by a controlling microprocessor.

LEVEL SHIFTING THE OUTPUT RANGE

As shown in *Figure 4*, the zero code output of the DAC can be shifted, if desired, to any level by summing a fixed current to the DAC's current output terminal, offsetting the output voltage of the op amp. The applied reference voltage now serves as the output span controller and is fractionally added to the output as a function of the applied code.

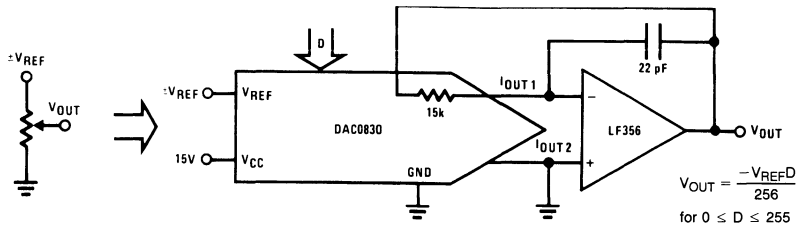


FIGURE 2. The Digital Pot

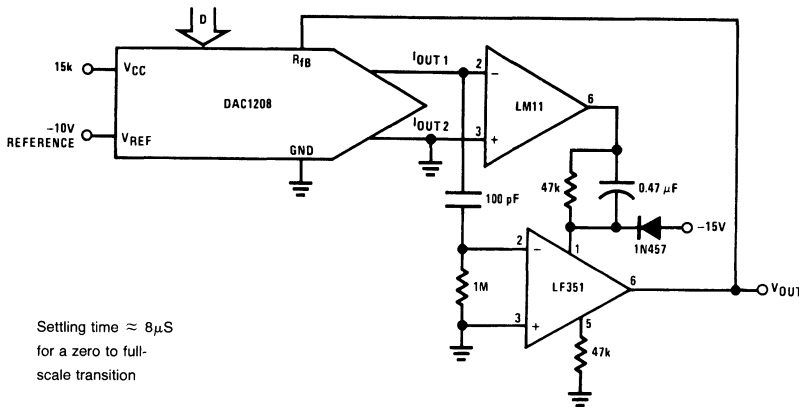


FIGURE 3. Composite Amplifier for Good DC Characteristics and Fast Output Response

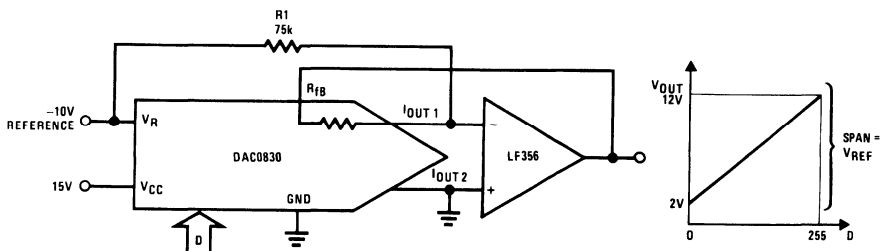


FIGURE 4. Level Shifted Output

$$V_{OUT} = -V_{REF} \left[\frac{R_{FB}}{R_1} + \frac{D}{256} \right]$$

TL/H/5629-1

SINGLE SUPPLY OPERATION

The R-2R ladder can be operated as a voltage switching network to circumvent the output voltage inversion inherent in the current switching mode. This allows single supply operation. In *Figure 5*, the reference voltage is applied to the I_{OUT 1} terminal, and is attenuated by the R-2R ladder in proportion to the applied code, and output to the V_{REF} terminal with no phase inversion. To insure linear operation in this mode, the applied reference voltage must be kept less than 3V for the 10-bit DACs or less than 5V for the 8-bit DACs. The applied supply voltage to the DAC must be at least 10V more positive than the reference voltage to insure that the CMOS ladder switches have enough voltage overdrive to fully turn on. An external op amp can be added to provide gain to the DAC output voltage for a wide overall output span.

The zero code output voltage is limited by the low level output saturation voltage of the op amp. The 2 kΩ load resistor helps to minimize this voltage. Specified DAC

linearity can be obtained in this circuit with the 8 and 10-bit MICRO-DAC, but is difficult because of the very low value reference required with the 12-bit parts. The resistance to ground of the V_{REF} terminal is nominally 15 kΩ, independent of the digital input code.

BIPOLAR OUTPUT FROM A FIXED REFERENCE VOLTAGE

The use of a second op amp in the analog output circuitry can provide a bipolar output swing from a fixed reference voltage. This, in effect, gives sign significance to the MSB of the digital input word to allow 2-quadrant multiplication of the reference voltage. The polarity of the reference can still be reversed or be an AC signal to realize full 4-quadrant multiplication. This circuit is shown in *Figure 6*.

Only the input offset voltage of amplifier OA 1 needs to be nulled to preserve the linearity of the DAC. The offset of OA 2 will affect only absolute accuracy of the output voltage.

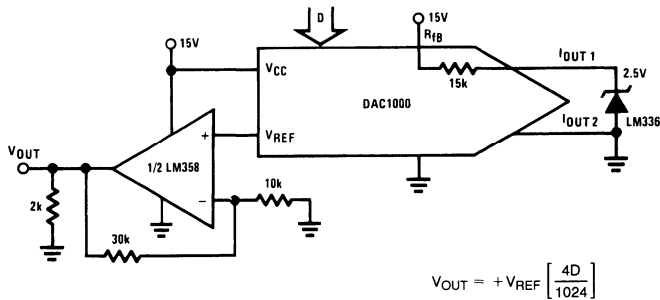
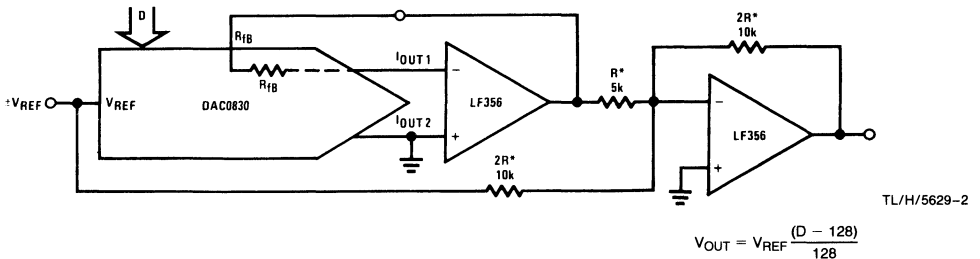


FIGURE 5. Single Supply Operation



TL/H/5629-2

*These resistors are available from Beckman Instruments, Inc. as their part no. 694-3-R10K-Q

$$1 \text{ LSB} = \frac{|V_{REF}|}{128}$$

Input Code MSB . . . LSB	Ideal V _{OUT}	
	+V _{REF}	-V _{REF}
1 1 1 1 1 1 1	V _{REF} - 1 LSB	- V _{REF} + 1 LSB
1 1 0 0 0 0 0	V _{REF} /2	- V _{REF} /2
1 0 0 0 0 0 0	0	0
0 1 1 1 1 1 1	-1 LSB	+1 LSB
0 0 1 1 1 1 1	$-\frac{ V_{REF} }{2} - 1 \text{ LSB}$	$\frac{ V_{REF} }{2} + 1 \text{ LSB}$
0 0 0 0 0 0 0	- V _{REF}	+ V _{REF}

FIGURE 6. Bipolar Output from a Fixed Reference Voltage

DAC CONTROLLED AMPLIFIER

In the circuit of *Figure 7*, the DAC is used as the feedback element for an inverting amplifier configuration. The R-2R ladder digitally adjusts the amount of output signal fed back to the amplifier's summing junction. The feedback resistance can be thought of as varying from $\approx 15\text{ k}\Omega$ to ∞ as the input code changes from full-scale to zero. The internal R_{FB} is used as the amplifier's input resistor. It is important to note that when the input code is all zeros the feedback loop is opened and the op amp output will saturate.

CAPACITANCE MULTIPLIER

The DAC controlled amplifier can be used in a capacitance multiplier circuit to give a processor control of a system's time or frequency domain response. The circuit in *Figure 8* uses the DAC to adjust the gain of a stage with a fixed capacitive feedback, creating a Miller equivalent input capacitance of the fixed capacitance times $1 +$ the amplifier's gain. The voltage across the equivalent input capacitance to ground is limited to the maximum output voltage of op amp A1, divided by $1 + 2^n/D$, where n is the DAC's bits of resolution.

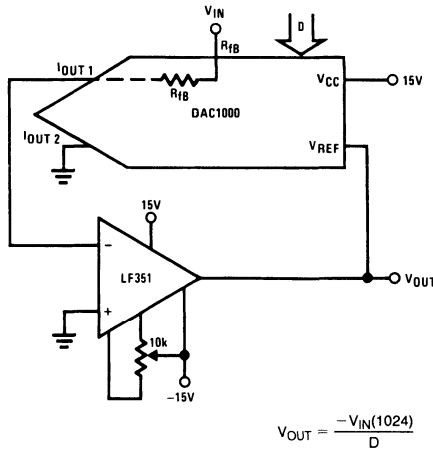
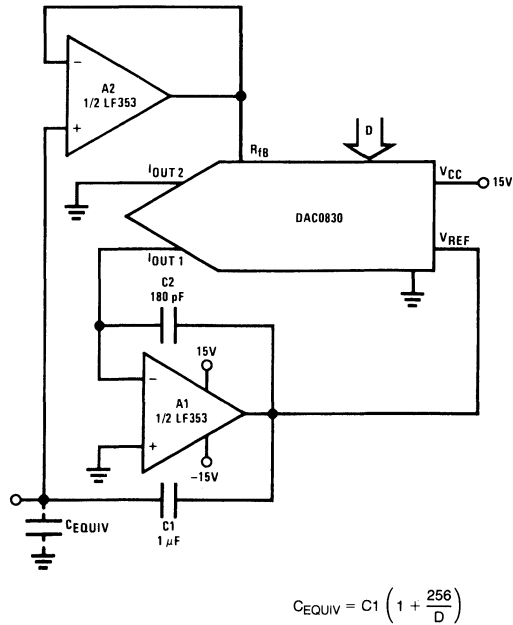


FIGURE 7. DAC Controlled Amplifier



TL/H/5629-3

FIGURE 8. Capacitance Multiplier

HIGH VOLTAGE OUTPUT

Many DAC applications involve the generation of high voltage levels to be used for deflection plate driving, high voltage motor speed, or position control. All of the MICRO-DAC can control as much as $\pm 25V$ applied to the reference terminal, but guaranteed performance is specified at no more than $\pm 10V$. Since the output amplifier serves as a current-to-voltage converter, increasing the effective feedback resistance directly increases the amplifier's output voltage for a given DAC output current. Use of a high voltage op amp, the LM143 with 80V supply capability for example, can accommodate this increased gain and allow the use of reference voltage within the DAC's specified limits. Figure 9 illustrates how higher voltage outputs can be obtained for both unipolar and bipolar requirements.

The output current of these circuits is limited to that of the LM143, typically 20 mA. If higher voltage and/or higher output current is needed, a discrete power stage can be used, as shown in Figure 10.

To insure accuracy with these high voltage circuits, concern for the power dissipation and temperature coefficients of the resistors used to increase the output voltage is necessary. The T-network configuration shown in Figure 10 reduces the dependence of the output voltage to temperature changes by reducing the significance of the tracking requirements of the external resistors to the internal R_{FB} resistor. Using two resistors with similar temperature coefficients for R1 and R2, and making their ratio dominant in setting the overall gain provide the most stable results.

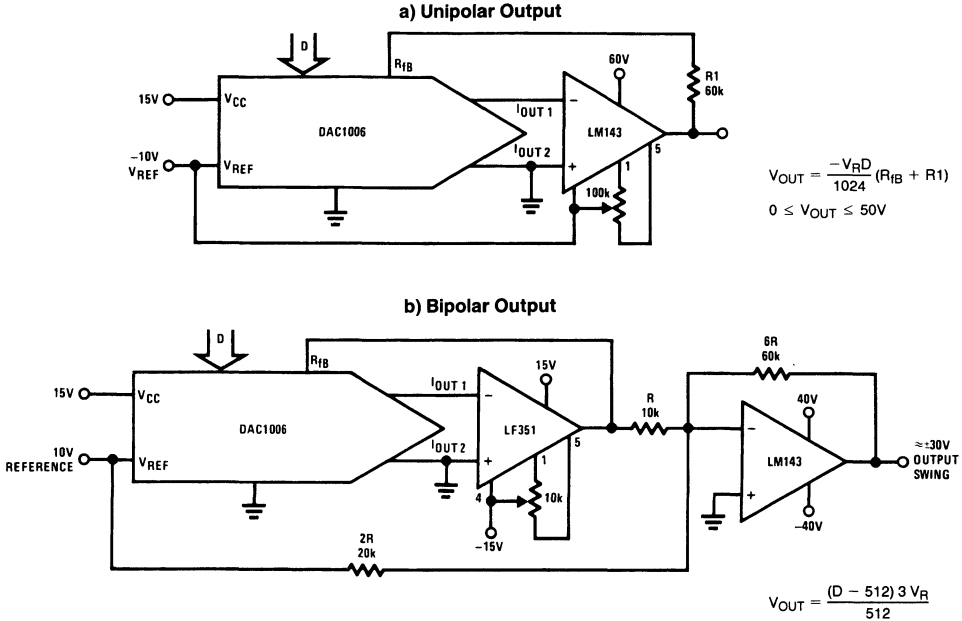


FIGURE 9. Unipolar and Bipolar Voltage Boosting

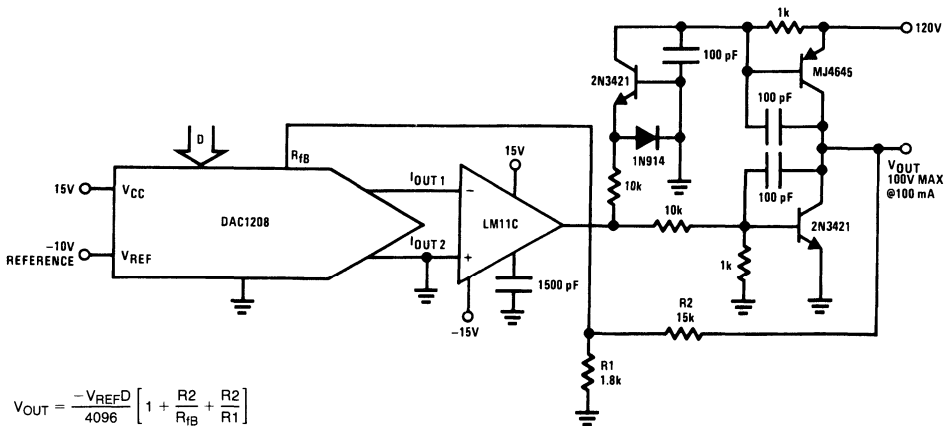


FIGURE 10. High Voltage Power DAC

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HIGH CURRENT CONTROLLER

The MICRO-DAC can also be used to linearly control current flow useful in applications such as automatic test systems, stepper-motor torque compensation, and heater controls. *Figure 11* illustrates the use of a DAC1230 controlling a 0A to 1A current sink. The largest source of nonlinearity in this circuit is the stability of the current sensing resistance with changes in its power dissipation. To minimize this effect, the sensing resistance should be kept as low as possible. To maintain the output current range, the reference voltage to the DAC must be reduced. The flexible reference requirements of the MICRO-DAC permit the application of a lower reference with no degradation in linearity. A triple Darlington is used to minimize the base current term flowing through the sense resistor, but not into the collector terminal.

4 ma to 20 mA CURRENT LOOP CONTROLLER

The standard 4 mA – 20 mA industrial process current loop controller is an application where automatic, microprocessor directed operation is often required, and is a natural application for D to A converters. The low power requirements of the CMOS MICRO-DAC allow the design of a controller that is powered directly from the loop it is controlling. *Figure 12* illustrates a 2-terminal floating 4 mA to 20 mA controller.

In this circuit, the output transistor will conduct whatever current is necessary to keep the voltage across R3 equal to the voltage across R2. This voltage, and therefore the total loop current, is directly proportional to the output current from the DAC. The net resistance of R1 is used to set the zero code loop current to 4 mA, and R2 is adjusted to provide the 16 mA output span with a full-scale DAC code.

The entire circuit "floats" by operating at whatever ground reference potential is required by the total loop resistance and loop current. To insure proper operation, the voltage differential between the input and output terminals must be kept in the range of 16V to 55V, and the digital inputs to the DAC must be electrically isolated from the ground potential of the controlling processor. This isolation can best be achieved with opto-isolators switching the digital inputs to the ground potential of the DAC for a logic low level.

In a non-microprocessor based system where the loop controlling information comes from thumbwheel switches, the digital input data for the DAC can be derived from BCD to binary CMOS logic circuitry, which is ground referenced to the ground potential of the DAC. The total supply current requirements of all circuits used must, of course, be less than 4 mA, and the value of R1 could be adjusted accordingly.

TARE COMPENSATION/AUTO-ZEROING

Probably the most popular application of D to A converters is in auto-zeroing or auto-referencing. In these systems the DAC is called upon to hold an output voltage to offset the analog input range of an A to D converter. This is done to reserve the full input range of the A to D for analog voltages starting from reference potential to a full-scale value relative to that reference voltage. A common example of this is Tare Compensation in a weighing system where the weight of the scale platform, and possibly a container, is subtracted automatically from the total weight being measured. This, in effect, expands the range of weight that could be measured by preventing a premature full-scale reading, and allows an automatic indication of the actual unknown quantity.

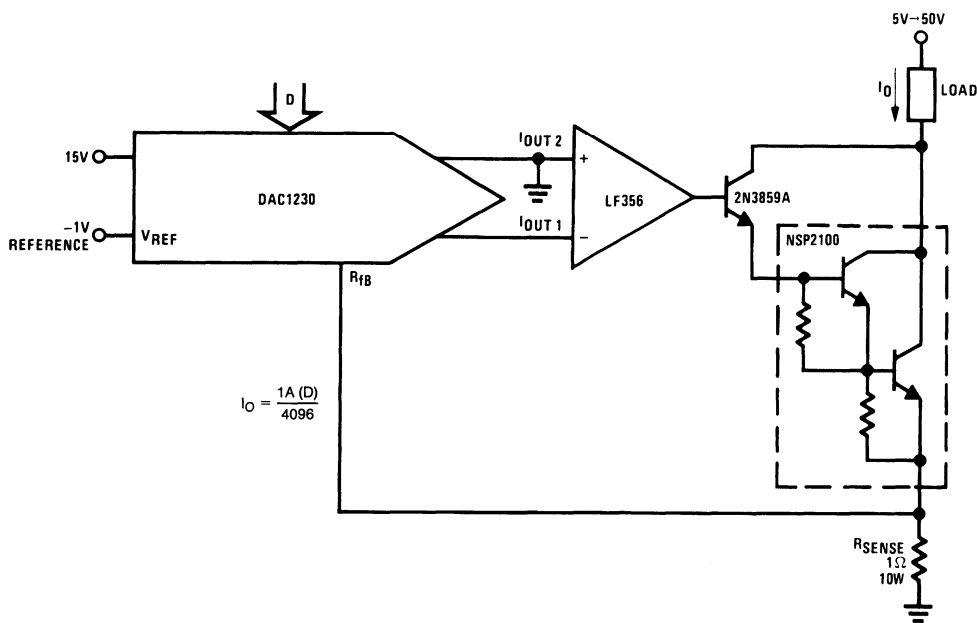


FIGURE 11. High Current Controller

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Figure 13 illustrates this basic technique. In this system the DAC would initially be given a zero code and the system's input would be set to some reference quantity. A conversion of this input would be performed, then the corresponding code would be applied to the DAC. The output of the DAC will be equal to and of the opposite polarity as the input voltage to force the amplifier's output, and therefore the

A/D's input, to zero. The DAC's output is held constant so that any subsequent A/D conversions will yield a value relative in magnitude to the initial reference quantity. To insure that the output code from the A to D generates the proper DAC output voltage, the two devices should be driven from the same reference voltage.

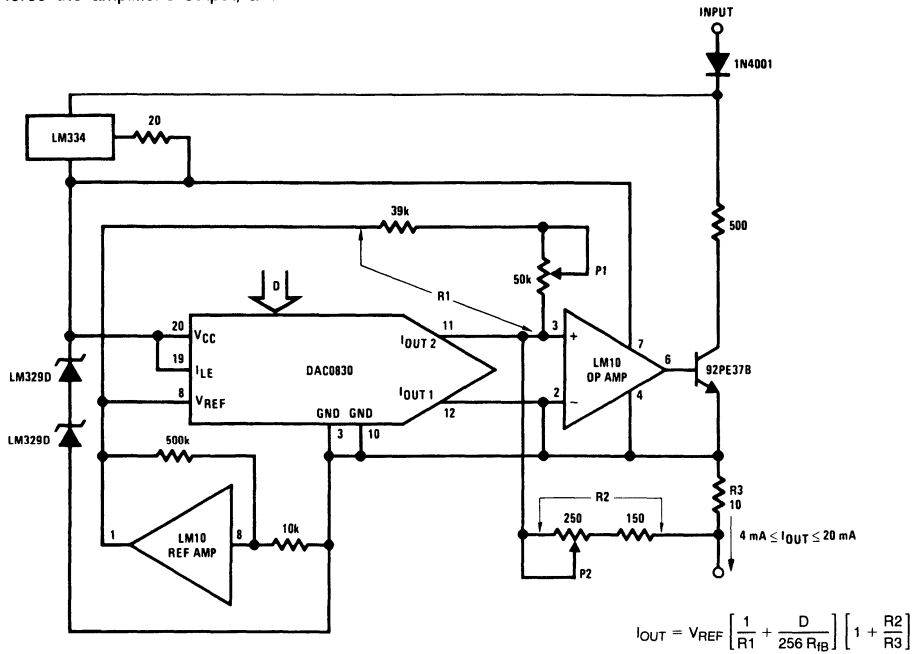


FIGURE 12. Two-Terminal 4 mA - 20 mA Current Loop Controller

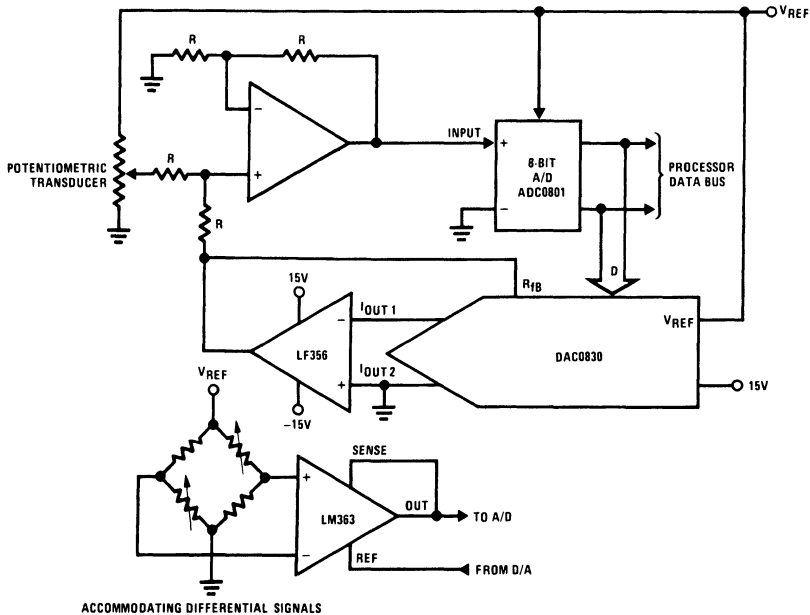


FIGURE 13. Basic Tare Compensation

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For differential input signals, an instrumentation amplifier such as the LM363 can be used. The output reference pin of this amplifier can be driven directly by the DAC's output amplifier to offset the A to D input.

Auto-zeroing is the unique case of auto-referencing where the reference input is the zero or null condition. This technique essentially shorts out or electrically simulates a balance of the system's input device, and uses a DAC to correct for offset errors contributed by the signal conditioning amplification stage. Since amplifier errors are generally much lower in magnitude than the signal after being amplified, and can be of either polarity when applied to the A/D, a bipolar output configuration utilizing a CMOS DAC (Figure 6) driven from a reduced reference voltage can null the offset errors to within microvolts of zero. This is illustrated in Figure 14 for an LM363 differential amplification stage.

The auto-zeroing routine performed by the processor is essentially a successive approximation routine which utilizes the A/D converter as a high resolution comparator, a feature unique to the ADC0801 A/D shown. When the routine

is completed, the voltage at the reference pin of the instrumentation amplifier will be equal to and of the opposite polarity of the amplifier's offset voltage, multiplied by the gain. Details of the A/D's operation in this mode and an example of a microprocessor successive approximation routine can be found on the ADC0801 data sheet.

D TO A CONVERTER WITH A VERNIER ADJUSTMENT

In many systems it is required that an analog voltage be generated as a controlling function by a processor, when only an approximate value is known, with the exact value dependent on feedback from the controlled device. In this case, the processor could output an 8-bit "coarse" word to the 8 MSBs of a 12-bit DAC. Then the 4 LSBs could be incremented or decremented by an up/down counter to serve as a 16 LSB dither or vernier, which would stop when external sensing circuitry detected the actual desired value. The DAC1208 can be used in just such a system, as shown in Figure 15. The digital input circuitry of this device

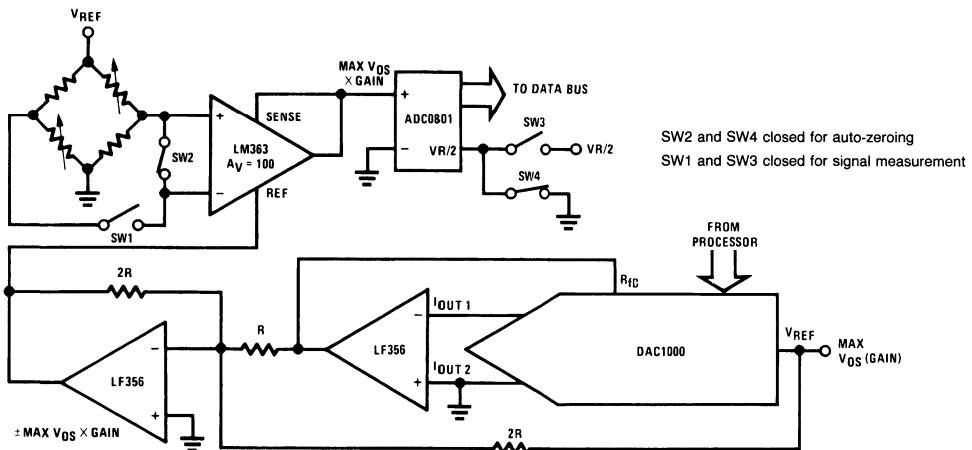


FIGURE 14. Auto-Zeroing

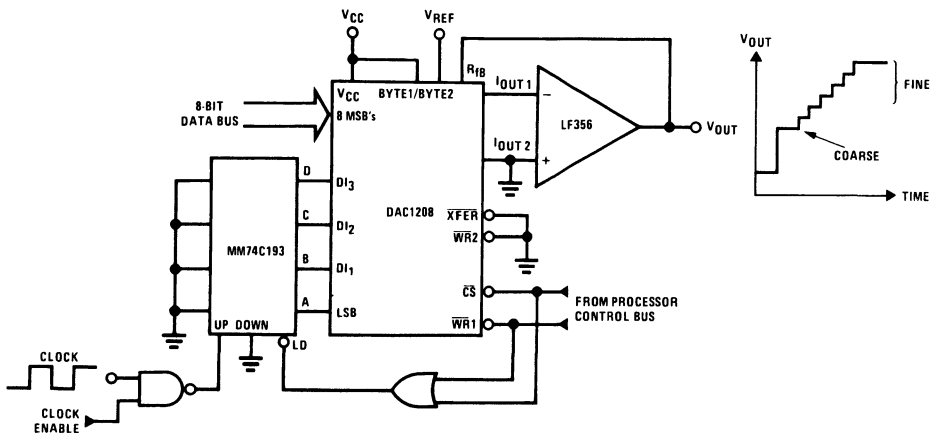


FIGURE 15. 8-Bit Coarse, 4-Bit Vernier DAC

TL/H/5629-7

provides all 12 input lines with separate registers for the 8 MSBs and the 4 LSBs. The register for the 4 LSBs can be configured to flow through so that the output will always reflect the state of the counter's output.

DAC CONTROLLED FUNCTION GENERATOR

CMOS DACs find wide use in the synthesis of periodic waveforms from digital information primarily for their precision and flexibility in controlling magnitude and timing parameters. If the signal generated is used as an excitation for a system, the data is readily available for a processor to know precisely where the input is to enable it to interpret the output response of the system. Typically, the data required to generate the amplitude information resides in the system ROM and the frequency is controlled by the rate at which the DAC is updated. Some of the more typical waveforms include sin, square, sawtooth ramps or staircases, and triangles.

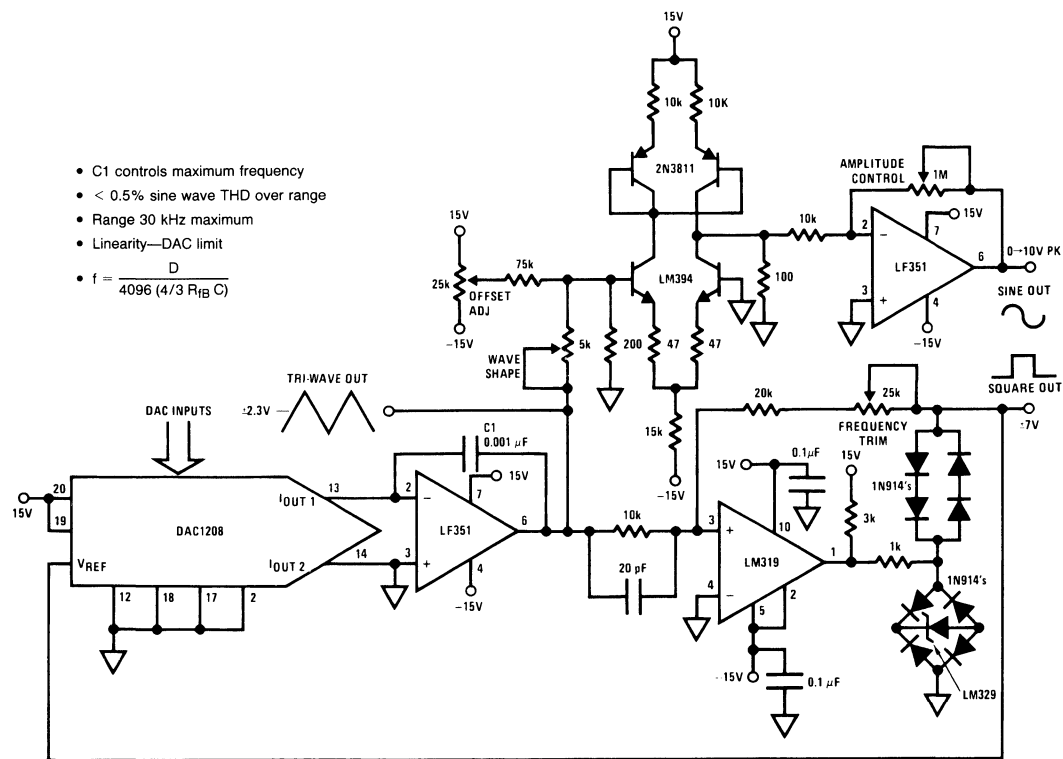
Figure 16 shows the implementation of a MICRO-DAC providing frequency control of a sine, square and triangle function generator. The DAC is used as a digitally programmable input resistor for an integrator. The bipolar nature of the reference input is important to the generation of a symmetrical triangle wave and a symmetrically clamped square wave. This allows the integrating capacitor to be ground referenced with equal charging and discharging currents.

Linearity of the output frequency versus the applied digital input code is as good as the DAC up to 30 kHz, where the propagation delay through the LM319 comparator starts adding non-linearity.

Integrating capacitor, C1, is selected for the maximum output frequency which occurs with a full-scale input code when the DAC provides its maximum output current. A problem in selecting this capacitor is that the R value of the internal R-2R ladder can vary over the range of 10 kΩ to 20 kΩ. This can be accommodated by adjusting the amount of positive feedback around the comparator to provide the desired maximum frequency for a given capacitor. This adjustment also alters the amplitude of the triangle wave, but this can be attenuated or amplified as required to achieve any desired amplitude.

The sine wave output is derived from the triangle wave by virtue of the non-linear conduction characteristics of the transistors used in the shaper circuit. The wave-shape adjustment is used to obtain minimum distortion of the sine wave output and should be adjusted after the triangle wave output is established.

The square wave output is a 50% duty cycle, symmetrical $\pm 7V$ signal. Since only $\frac{1}{2}$ of the LM319 dual comparator is used, the other side can be used to provide TTL or CMOS logic compatible output if needed.



- C1 controls maximum frequency
- < 0.5% sine wave THD over range
- Range 30 kHz maximum
- Linearity—DAC limit
- $f = \frac{D}{4096 (4/3 R_{FB} C)}$

FIGURE 16. DAC Controlled Function Generator

TL/H/5629-8

For DAC controlled amplitude versatility, the basic unipolar configuration (Figure 2) can be used at any or all of the outputs.

LOGARITHMIC AMPLIFIER WITH A PROGRAMMABLE SCALE FACTOR

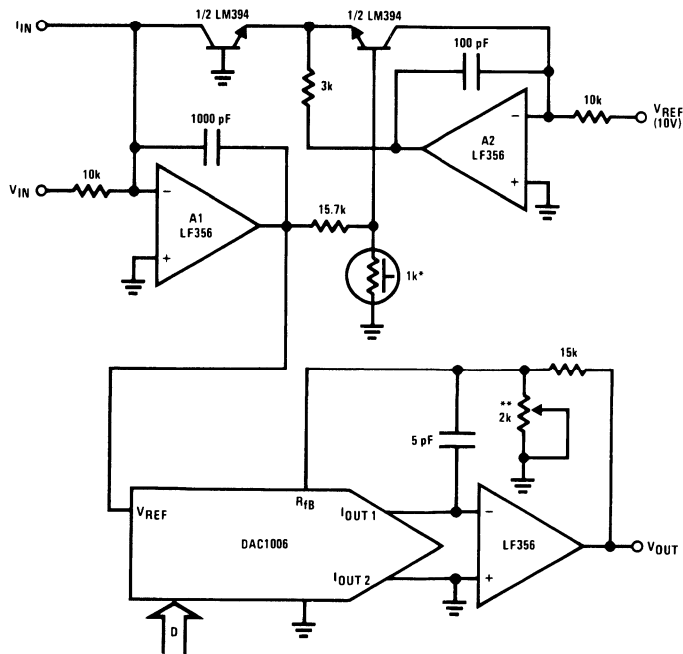
Sensors that operate over a wide dynamic range, such as photomultiplier tubes, often require signal compression via logarithmic amplifiers. Figure 17 shows a logging amplifier with a digitally programmable output scale factor from 10 mV/decade to 10V/decade over an input voltage range of 100 μV to 10V, or an input current range of 10 nA to 1 mA. The DAC1006 is used as the scaling element to attenuate or amplify the logarithmic output.

SUMMARY

The circuits described in this note illustrate only a very small percentage of possible MICRO-DAC applications. The key points to remember when considering the use of one of these devices are summarized below.

1. The reference voltage can be a bipolar AC or DC signal within the range of 25V with specified linearity guaranteed at ±10V and ±1V.

2. Low power consumption CMOS circuitry (20 mW typ).
3. Direct microprocessor interface with the necessary controlling logic designed in. All parts are 8-bit bus compatible.
4. TTL compatible digital input thresholds independent of the DAC's V_{CC} supply.
5. Linearity is guaranteed over temperature following a simple zero and full-scale adjustment procedure.
6. The current outputs, I_{OUT 1} and I_{OUT 2}, want to be at ground potential.
7. I_{OUT 1} should always be used in conjunction with the internally provided feedback resistor, as this resistor matches and tracks with temperature the resistors used in the R-2R ladder network.
8. The internal R value can vary over a 10 kΩ to 20 kΩ range.
9. The 12-bit MICRO-DAC are not recommended for use in the voltage switching mode.



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*Tel Labs Q81 (+ 0.3%/°C)

**Adjust for 10V/dec output sensitivity at full-scale input code

$$V_{OUT} = \frac{10D}{1024} \log \frac{V_{IN}}{V_{REF}}$$

FIGURE 17. Logarithmic Amplifier with Digitally Programmable Scale Factor



Although modern integrated circuit operational amplifiers ease linear circuit design, IC processing limits amplifier output power. Many applications, however, require substantially greater output voltage swing or current (or both) than IC amplifiers can deliver. In these situations an output "booster," or post amplifier, is required to achieve the needed voltage or current gain. Normally, this stage is placed within the feedback loop of the operational amplifier so that the low drift and stable gain characteristics of the amplifier are retained. Because the booster is a gain stage with its own inherent AC characteristics, the issues of phase shift, oscillation, and frequency response cannot be ignored if the booster and amplifier are to work well together. The design of booster stages which achieve power gain while maintaining good dynamic performance is a difficult challenge. The circuitry for boosters will change with the application's requirements, which can be very diverse. A typical current gain stage is shown in *Figure 1*.

200 mA CURRENT BOOSTER

The circuit of *Figure 1* boosts the LF356 unity gain inverter amplifier's output current to a ± 200 mA level while maintaining a full ± 12 V output swing. The LM334 current sources are used to bias complementary emitter-followers. The 200Ω resistors and D1-D4 diodes associated with the LM334s provide temperature compensation for the current sources, while the 20Ω resistor sets the current value at 3.5 mA. Q1 provides drive for positive LF356 output swings, while Q2 sinks current for negative amplifier outputs. Crossover distortion is avoided by the D2-D3 diodes which compensate the V_{BE} s of Q1 and Q2. For best results, D2 and D3 would be thermally coupled to the TO-5 type heat sinks used for Q1 and Q2. Amplifier feedback is taken from the booster output and returned to the LF356 summing junction. D5 and D6 achieve short circuit protection for the output by shunting drive from Q1 or Q2 when output current exceeds

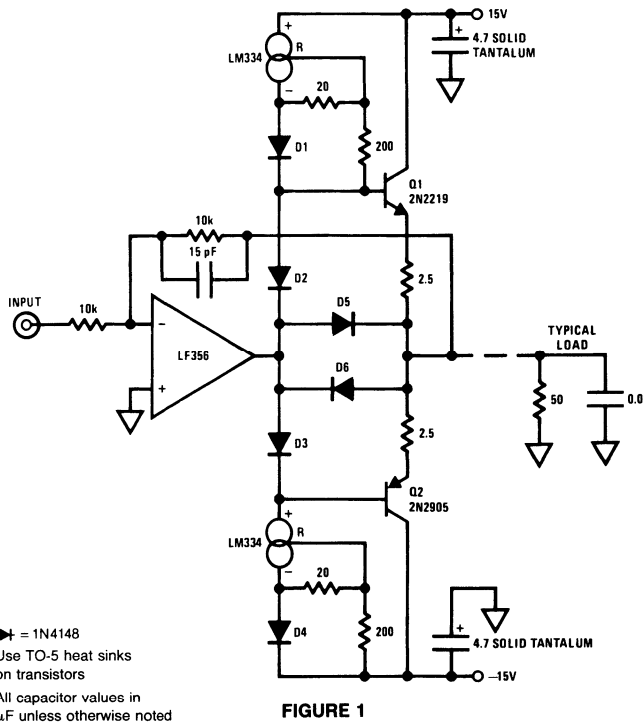
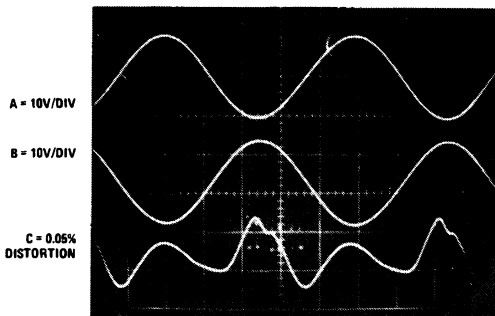


FIGURE 1

TL/H/5630-1

about 275 mA. This value is derived from the output 2.5Ω resistors value divided by the 0.7V drop across the diodes. The 15 pF-10k feedback values provide a roll-off above 2 MHz. *Figure 2* shows the circuit at work driving a 100 kHz 20 Vp-p sine wave into a 50Ω load paralleled by 10,000 pF/Trace A is the input, while Trace B is the output. Despite the heavy load, response is clean below and quick with overall circuit distortion 0.05% (Trace C).

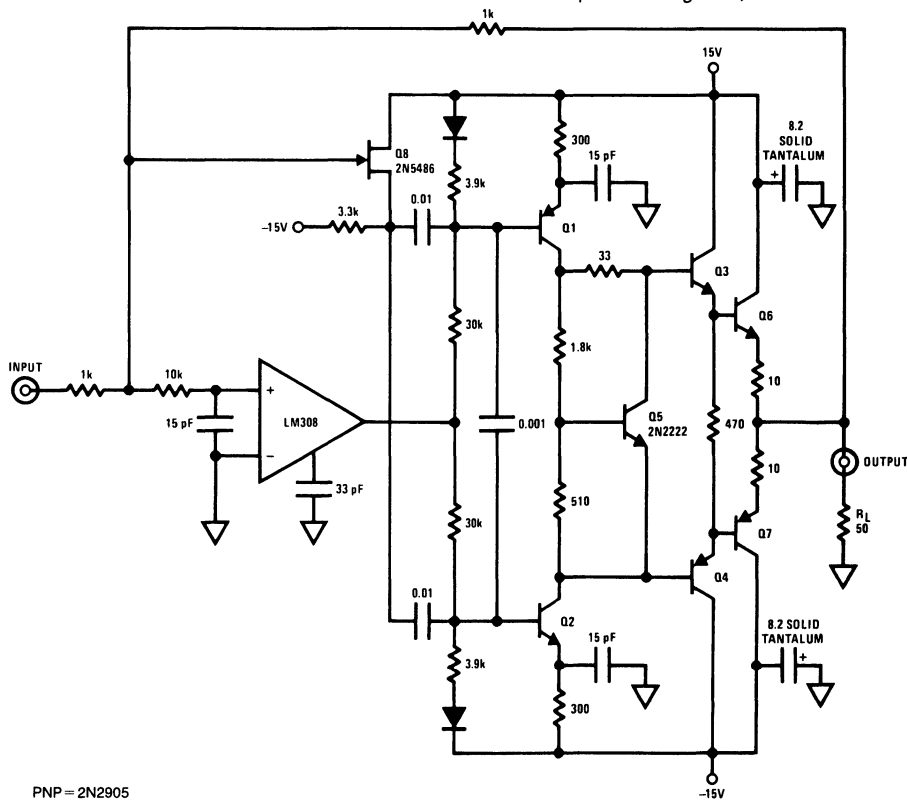


TL/H/5630-2

FIGURE 2

ULTRA HIGH SPEED FED-FORWARD CURRENT BOOSTER

The schematic of *Figure 3* features the same output specifications as the previous current booster, but provides much greater speed. The speed of the booster in *Figure 1* is limited by the response of the op amp which drives it. Because that booster resides in the op amp's feedback loop, it cannot go any faster than the op amp, even though it has inherently greater bandwidth. In *Figure 3* we employ a feed-forward network which allows AC signals to bypass the LM308 op amp and directly drive a very high bandwidth current boost stage. At DC and low frequencies the LM308 provides the signal path to the booster. In this fashion, a very high speed, high current output is achieved without sacrificing the DC stability of the op amp. The output stage is made up of the Q1 and Q2 current sources which bias complementary emitter-followers, Q3-Q6 and Q4-Q7. Because the stage inverts, feedback is returned to the non-inverting input of the LM308. The actual summing junction for the circuit is the meeting point of the 1k resistors and the 10k unit at the LM308. The 10k-15 pF combination prevents the LM308 from seeing high frequency inputs. Instead, these inputs are source-followed by the Q8 FET and fed directly to the output stage via the two 0.01 μ F capacitors. The LM308, therefore, is used to maintain loop stability only at DC and low frequencies. Although this arrangement is substantially more complex than *Figure 1*, the result is a breathtaking



PNP = 2N2905

NPN = 2N2219 unless noted

TO-5 heat sinks for Q6-Q7

FIGURE 3

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increase in speed. This boosted amplifier features a slew rate of 750V per microsecond, a full power bandwidth over 6 MHz and a 3 dB point beyond 11 MHz while retaining a $\pm 12V$, 200 mA output. Figure 4 shows the amplifier-booster at work. Trace A is the input, while Trace B is the output. The booster drives a 10V pulse into 50 Ω , with rise and fall times inside 15 ns and clean settling characteristics.

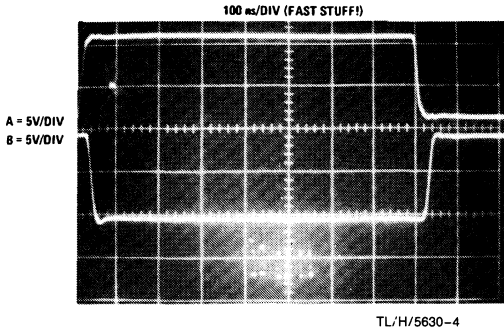


FIGURE 4

VOLTAGE-CURRENT BOOSTER

In many applications it is desirable to obtain voltage gain from a booster stage. Most monolithic amplifiers will only swing $\pm 12V$, although some types, such as the LM143, can swing $\pm 35V$. The circuit of Figure 5 shows a simple way to effectively double the voltage swing across a load by stacking or "bridging" amplifier outputs. In the circuit shown, LF0002 current amplifiers are included in each LF412 output to provide current drive capability. Because one amplifier inverts and the other does not, the load sees 24V across

it for $\pm 12V$ swings from each amplifier. With the LH0002 current buffers, 24V can be placed across a 250 Ω load. Although this circuit is simple and no high voltage supplies are needed, it requires that the load float with respect to ground.

$\pm 120V$ SWING BOOSTER

In Figure 6 the load does not have to float from ground to be driven at high voltage. This booster will drive a 2000 Ω load to $\pm 100V$ with good speed. In this circuit, voltage gain is

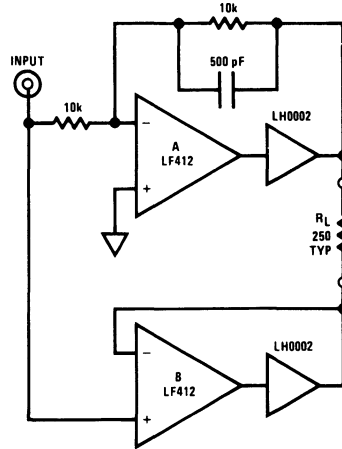
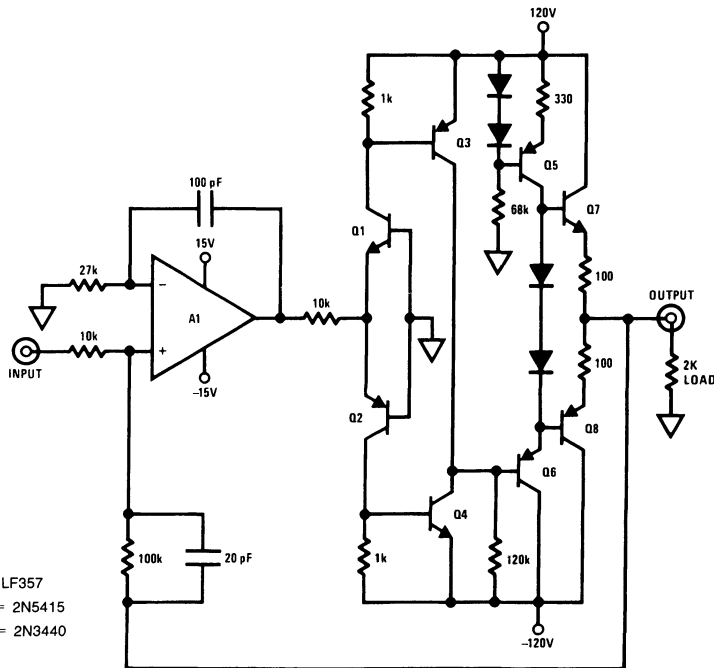


FIGURE 5



A1 = LF357
PNP = 2N5415
NPN = 2N3440

FIGURE 6

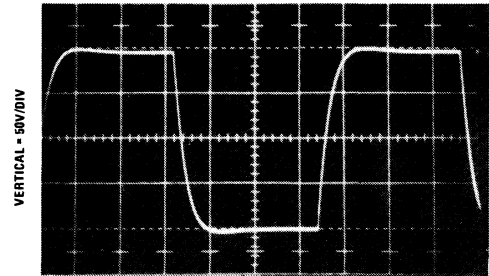
TL/H/5630-5

obtained from the complementary common base stage, Q1-Q2. Q3 and Q4 provide additional gain to the Q7-Q8 complementary emitter-follower output stage. Q5 and Q6 provide bias, and crossover distortion is minimized by the diodes in Q5's collector line. For $\pm 10\text{V}$ input signals, A1 must operate at a minimum gain of 10 to achieve a $\pm 100\text{V}$ swing at the output. In this case, 10k-100k feedback values are used for a gain of ten, and the 20 pF capacitor provides loop roll-off. Because the booster contains an inverting stage (Q3-Q4), overall feedback is returned to A1's positive input. Local AC feedback at A1's negative input provides circuit dynamic stability. With its $\pm 50\text{ mA}$ output, this booster yields currents as well as voltage gain. In many applications, such as CRT deflection plate driving, this current capability is not required. If this is the case, Q5 through Q8 and their associated components can be eliminated and the output and feedback taken directly from the Q3-Q4 collector line. Under these conditions, resistive output loading should not exceed $1\text{ M}\Omega$ or significant crossover distortion will appear. Since deflection plates are a pure capacitive load, this is usually not a problem. *Figure 7* shows the boosted amplifier driving a $\pm 100\text{V}$ square wave into a 2000Ω load at 30 kHz.

HIGH CURRENT BOOSTER

High current loads are well served by the booster circuit of *Figure 8*. While this circuit does provide voltage gain, its ability to drive 3A of current into an 8Ω load at 25V peak

makes it useful as a current booster. In this circuit, the LM391-80 driver chip and its associated power transistors are placed inside the LF411's feedback loop. The 5 pF capacitor at pin 3 of the LM391-80 sets the booster bandwidth well past 250 kHz. The 100k-10k feedback resistors set a gain of ten, and the 100 pF feedback capacitor rolls off the loop gain at 100 kHz to insure stability for the amplifier-booster combination. The 2.7Ω - $0.1\mu\text{F}$ damper network and the $4\mu\text{H}$ inductor prevent oscillations. The zero signal current of the output stage is set with the 10k potentiometer (pins 6-7 at the LM391) while a DVM is monitored for 10 mV across the 0.22Ω output resistors.



HORIZONTAL = 5 μs /DIV

TL/H/5630-6

FIGURE 7

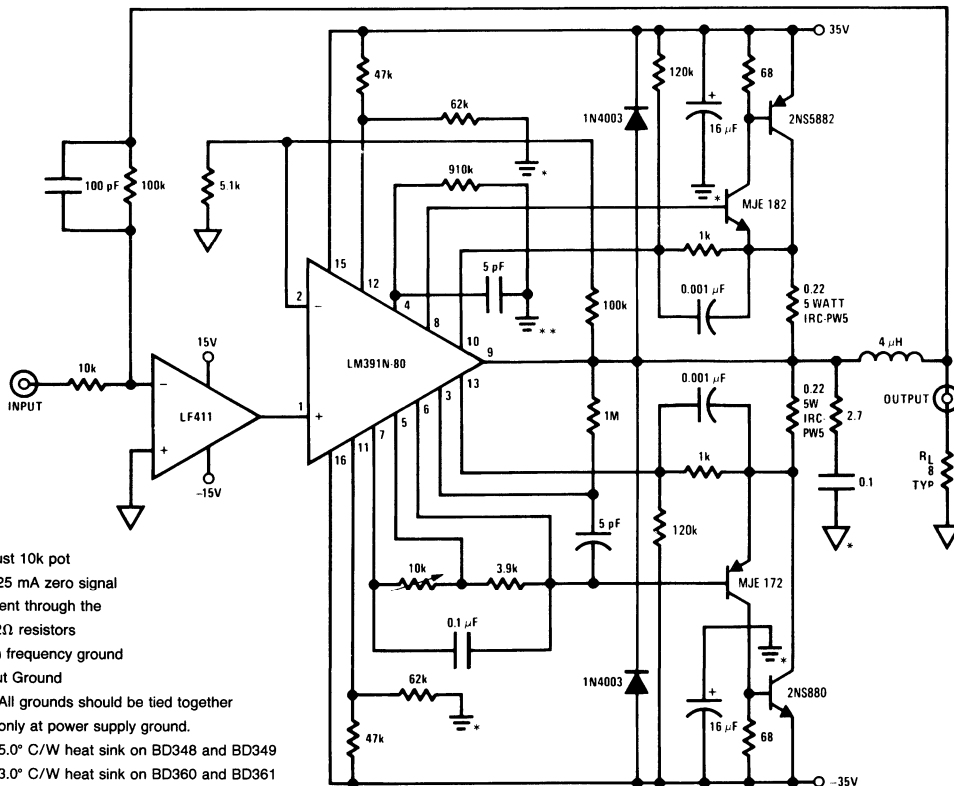


FIGURE 8

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INDESTRUCTIBLE, FLOATING OUTPUT BOOSTER

Figure 9 shows how a high quality audio amplifier can be used as a current-voltage booster for AC signals. The audio amplifier, specified as the booster, is a venerable favorite in research labs, due to its transformer isolated output and clean response. The LF356 op amp's loop is closed locally at a DC gain of 100, and rolled off at 50 kHz by the 200 pF capacitor. The audio amplifier booster's output is fed back via the 100k resistor for an overall AC gain of 100 with respect to the booster amplifier output. The arrangement is ideal for laboratory use because the vacuum tube driven transformer isolated output is extremely forgiving and al-

most indestructible. AC variable frequency power supplies, shaker table drives, motors and gyro drives, as well as other difficult inductive and active loads, can be powered by this booster. Power output is 75W into 4Ω-16Ω, although loads of 1Ω can be driven at reduced power output.

1000V-300 mA BOOSTER

Figure 10 diagrams a very high voltage, high current booster which will allow an op amp to control up to 300W for positive outputs up to a staggering 1000V. This performance is achieved without sacrificing efficiency because this booster, in contrast to all the others shown, operates in a switching

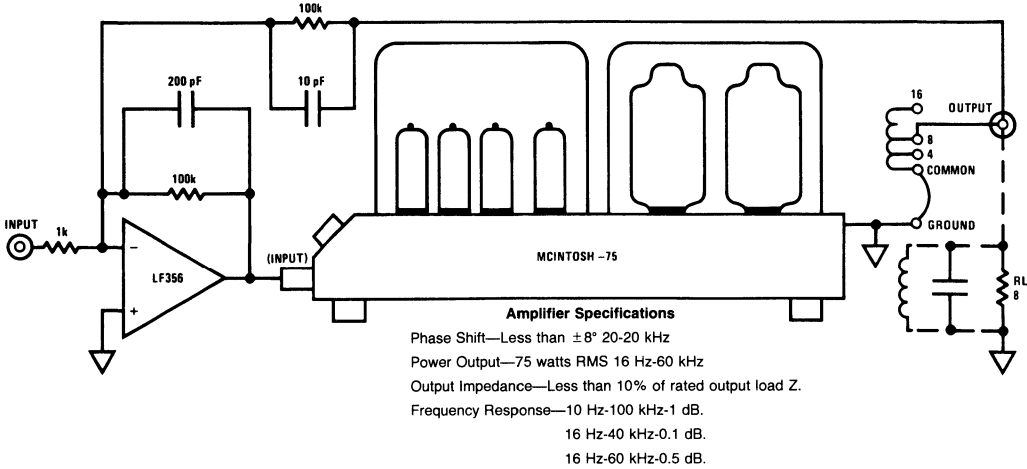


FIGURE 9

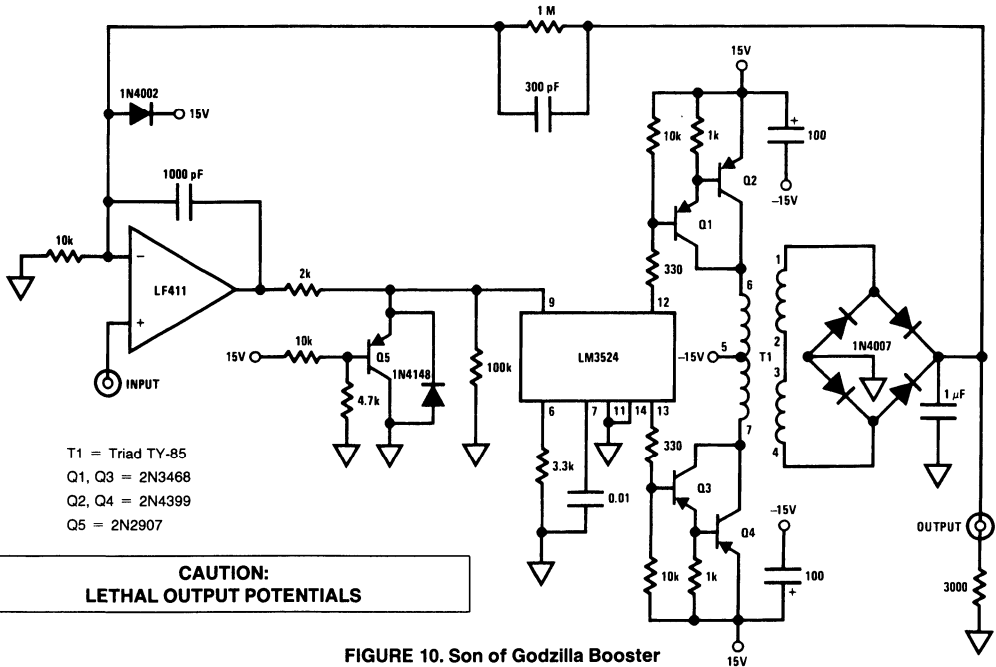


FIGURE 10. Son of Godzilla Booster

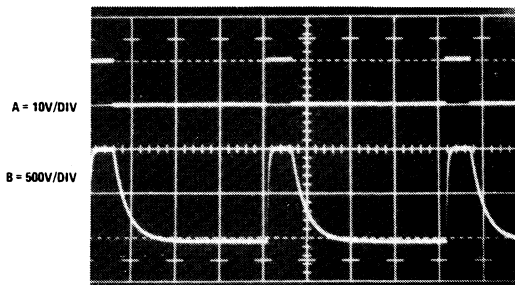
mode. In addition, this booster runs off $\pm 15V$ supplies and has the highly desirable property of *not* requiring a high voltage power supply to achieve its high potential outputs. The high voltage required for the output is directly generated by a switching DC-DC converter which forms an integral part of the booster. The LM3524 switching regulator chip is used to pulse width modulate the transistors which provide switched 20 kHz drive to the TY-85 step-up transformer. The transformer's rectified and filtered output is fed back to the LF411, which controls the input to the LM3524 switching regulator. In this manner, the high voltage booster, although operating switched mode, is controlled by the op amp's feedback action in a similar fashion to all the other designs. Q5 and the diode act as clamps to prevent the LF411's output swing from damaging the LM3524's 4V input on start-up. The diode at the LF411 swing junction prevents high voltage transients coupled through the feedback capacitor from destroying the amplifier. The 1 M Ω -10k feedback resistors set the gain of the amplifier at 100 so that a 10V input will give a 1000V output. Although the 20 kHz torroid switching rate places an upper limit on how fast information can be transmitted around the loop, the 1 μ F filter capacitor at the circuit output restricts the bandwidth. For the design shown, full power sine wave output frequency is 55H. Figure 11 shows the response of the boosted LF411 when a 10V pulse (Trace A) is applied to the circuit input. The output (Trace B) goes to 1000V in about 1 ms, while fall time is about 10 ms because of capacitor discharge

time. During the output pulse's rise time the booster is slow rate limited and the switching action of the torroid is just visible in the leading edge of the pulse.

The reader is advised that the construction, testing and use of this circuit must be approached with the greatest care. The output potentials produced are many times above the level which will kill. Repeating, the output of this circuit is lethal.

300V OUTPUT BOOSTER

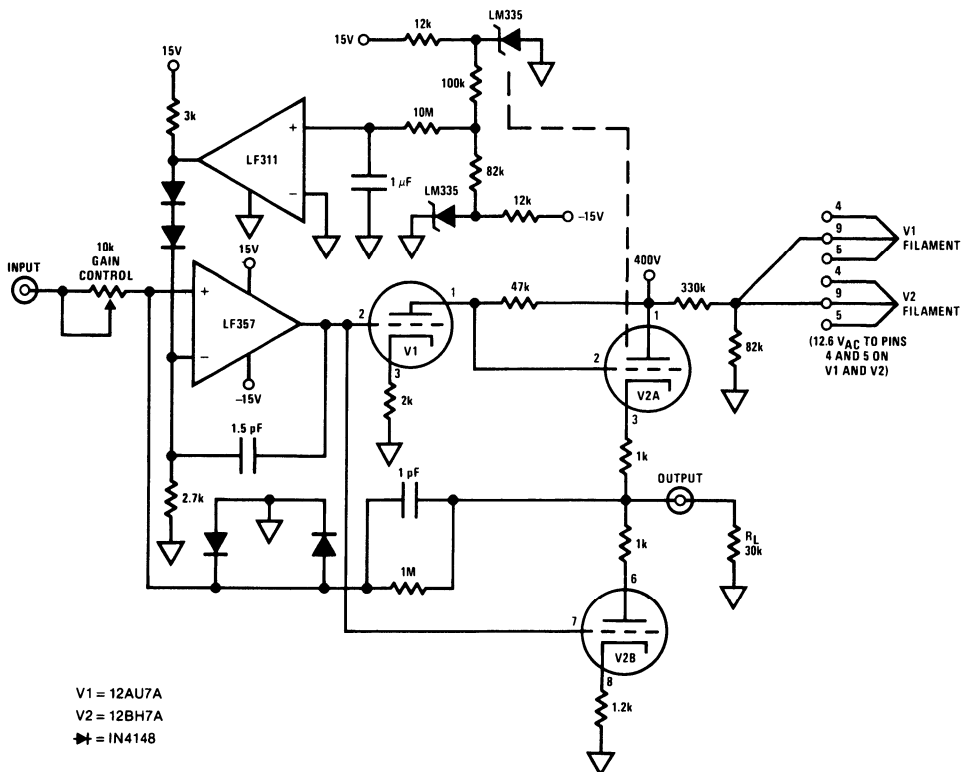
The circuit of Figure 12 is another high voltage booster, but will only provide 10 mA of output current. This positive-output-only circuit will drive 350V into a 30k load, and is almost



HORIZONTAL = 10 ms/DIV

TL/H/5630-9

FIGURE 11



V1 = 12AU7A
 V2 = 12BH7A
 = IN4148

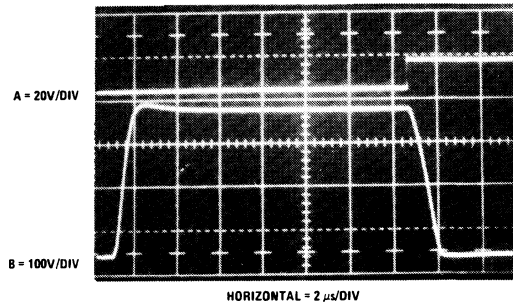
FIGURE 12

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immune to load shorts and reverse voltages. A solid state output requires substantial protection against these conditions. Although the circuit shown has a 350V limit, tubes (remember them?) with higher plate voltage ratings can extend the output capacity to several kilovolts. In this circuit, our thermionic friends are arranged in a common cathode (V2B) loaded-cathode-follower (V2A) output, driven from a common cathode gain stage (V1). The booster output is fed back to the LF357 via the 1 M Ω resistor. Local feedback is used to stabilize the LF357, while the pF-1 M Ω pair rolls off the loop at 1 MHz. Because the V1 stage inverts, the feedback summing junction is placed at the LF357 positive input. The parallel diodes at the summing junction prevent high voltage from destroying the amplifier during circuit start-up and slew rate limiting. Tubes are inherently much more tolerant of load shorts and reverse voltages than transistors, and are much easier to protect. In this circuit, an LM335 temperature sensor is in contact with V2. This

sensor's output is compared with another LM335 which senses ambient temperature. Under normal operating conditions, V2 operates about 45°C above ambient and the "+" input of the LF311 is about -100 mV, causing its output to be low. When a load fault occurs, V2's plate dissipation increases, causing its associated LM335's output to rise with respect to ambient temperature. This forces the LF311's output high, which makes the LF357 output go low, shutting down the output stage. Adequate hysteresis is provided by the thermal time constant of V2 and the 10 M Ω -1 μ F delay in the LF311 input line. *Figure 13* shows the response of this amplifier booster at a gain of about 25. With a 15V input pulse (Trace A), the output (Trace B) goes to 350V in 1 μ s, and settles within 5 μ s. The falling edge slews equally fast and settling occurs within 4 μ s.

Figure 14 is a table which summarizes the information in this article and will help you to pick the right booster for your particular application.



TL/H/5630-11

FIGURE 13

Figure	Voltage Gain	Current Gain	Bandwidth	Comments
1	No	Yes—200 mA	Depends on op amp. Typical 1 MHz	Full "+" and "-" output swing. Stable into 50 Ω -10,000 pF load. Inverting or non-inverting operation. Simple.
3	No	Yes—200 mA	Full output to 5 MHz-3dB. Point at 11 MHz.	Ultra fast. 750V/ μ s. Full bipolar output. Inverting operation only.
5	Yes—24V swing	No	Depends on op amp.	Requires that load float from ground.
6	Yes— \pm 100V	Yes—50 mA	50 kHz typical.	Full "+" and "-" output swing. Allows inverting or non-inverting operation. Simplified version ideal for CRT deflection plate driving. More complex version drives full 200V swing into 2 k Ω and 1000 pF.
8	Yes— \pm 30V	Yes—3A	50 kHz	Full "+" and "-" output swing. Allows inverting or non-inverting operation.
9	Yes—70V swing	Yes—3A	100 kHz	Output extremely rugged. Well suited for driving difficult loads in lab. Set-ups. Full bipolar output. AC only.
10	Yes—1000V	Yes—300 mA	50 Hz	High voltage at high current. Switched mode operation allows operation from \pm 15V supplies with good efficiency. Limited bandwidth with asymmetrical slewing. Positive outputs only.
12	Yes—350V	No	500 kHz	Output very rugged. Good speed. Positive outputs only.

FIGURE 14

CMOS A/D Converter Interfaces Easily with Many Microprocessors

National Semiconductor
Application Note 274
Thomas Frederiksen



With a span accommodation down to 180 mV, this 8-bit unit can also replace a 12-bit analog-to-digital device in some applications.

To help meet the rising demand for easier interfacing between analog-to-digital converters and microprocessors, the complementary MOS, 8-bit ADC0801-05 has been designed to accommodate almost all of today's popular microprocessors. It requires only a single 5V supply and is low power to boot.

Housed in a 20-pin dual-in-line package, the successive approximation device includes a Schmitt trigger circuit that allows it to be driven from a system clock, as well as an external RC network. At a clock frequency of 640 kHz, conversion time is 100 μ s. What's more, its guaranteed linearity error of $\pm 1/4$ least significant bit (typically $\pm 1/16$ LSB) can encode an analog signal span as small as 180 mV—a performance that allows it to replace 9, 10, and even 12-bit converters in many applications.

Constantly decreasing converter prices raise the comparative cost of the interface electronics and increase the demand for simplicity of interfacing. The growing emphasis on simpler systems for higher levels of reliability has also pushed this demand, as has a trend toward lower levels of power dissipation. And with the success of the 5V power supply standard of logic circuits, linear circuits have been pressed for 5V operation. Supporting the ADC0801-05 A/D converter are such special operational amplifiers as the LM358 dual and the LM324 and LM3900 quad op amps that run off 5V supplies; also useful are voltage comparators such as the LM393 dual and LM339 quad devices. Perhaps the most versatile of such 5V linear devices is the LM392, comprising an op amp and a comparator.

MORE COMPLICATIONS

Complicating the interfacing are the ever higher levels of resolution in monolithic converters, with 8 and 10-bit types readily available and 12-bit devices ready to emerge soon. Yet, despite their greater resolution, 10 and 12-bit monolithic A/D converters are not only more expensive than 8-bit designs, but also require more careful attention to system noise problems and management of grounding.

For simple interfacing, an A/D converter must operate directly with the signals available on a microprocessor control bus. The converter is generally given an address that can be mapped into memory or input/output space, depending on the type of microprocessor employed. On 6800 microprocessors and their derivatives, no special input/output addressing or strobes are available, so the converter must appear as a memory location to these processors. Z80[®] microprocessors, on the other hand, not only provide special I/O interfacing, but also automatically insert a wait state dur-

ing I/O selection to increase the width of the read and write strobe signals. This eases interface requirements considerably, since slower I/O devices can operate with much faster microprocessor units. The automatic wait state for I/O devices will loom larger in importance as the next generation of higher speed microprocessors evolves.

COMPATIBILITY CRITERIA DIFFER

Microprocessor compatibility has a wide range of meanings—at least according to the various converter data sheets. True compatibility, however, involves meeting electrical specifications like proper logic voltage levels with adequate loading capability. For example, true TTL compatibility means the ability to maintain a 0.4V low potential (or less) at the A/D converter logic outputs while sinking 1.6 mA of current. And the high state must be maintained at a minimum of 2.4V while supplying at least 360 μ A.

Furthermore, all interface protocols must be met. This not only means operating with the proper signals, but also meeting all necessary timing requirements, so the converter must have valid data on the microprocessor bus within the access time of the memory system with which it happens to be working.

The protocols for interfacing are not at all standardized. Some A/D converters make use of the standard chip select signal (\overline{CS}) to start a conversion. But decoding voltage glitches can cause an A/D converter to begin conversion when it is not desirable. Both the standard \overline{CS} signal and a write strobe signal (\overline{WR}) must therefore be used, so that the former signal qualifies the latter and prevents unwanted conversions due to address decoding glitches. Care must also be taken when using some A/D converters that are designed to act as bus controllers; problems can arise when the central processor is not in control of the bus.

DIFFERENT STANDARDS

The 8080 and 6800 microprocessors (and their derivatives) use different control bus standards. Microprocessors based on the 8080, for example, make use of read and write strobe signals to specify the operation (read or write) requested. Working with these microprocessors, A/D converters start the conversion cycle upon the microprocessor's issuance of a chip select signal (decoded from the address bus) and a write strobe signal. At the end of conversion (EOC), the converter issues an EOC signal. When dealing with older A/D converters where the EOC signal is typically low during the conversion process and high at the end of it, microprocessors have difficulty because the EOC signal is not available on the data bus. Furthermore, the EOC signal does not reset when the converter is serviced by the central processing unit (that is, when data has been read).

Complications can also occur when microprocessors interface with older A/D devices during read operations. For proper interfacing, such converters must have valid data on the bus within the memory access time.

Interfacing requirements differ for 6800-type microprocessors, like the 6502 and 68000, which use read/write (R/W) control lines instead of read and write strobe signals and obtain timing information from the system clock signal. In addition, they include a valid memory address signal to qualify the address that is placed on the bus. Such features make interfacing for these microprocessors different from that for earlier 8080 types.

For an A/D converter to be most useful in a microprocessor-based system, it must have such desirable analog features as differential inputs, and it should adjust to accommodate various analog input signal ranges. The ADC0801-05 offers differential analog inputs, but it is the converter's span accommodation that allows many unusual and useful analog applications.

The availability of differential analog voltage inputs eliminates the problem of poor analog grounds, since both inputs can be connected directly across the analog signal source.

The negative (normally grounded) analog input lead can be referenced to any desired DC offset voltage to accommodate an input signal range that does not swing down to ground. A DC offset can thus be used at this input to cause a digital output of all 0s at any desired input voltage.

FLEXIBLE SPAN

Finally, the ability to accommodate an arbitrary span or input dynamic voltage range is desirable in an A/D converter. This can easily be achieved in the ADC0801-05 by selecting the magnitude of the converter's reference input.

An example might be to permit an analog input voltage range of 0.5V to 3.5V. This is accomplished by tying the

converter's negative input lead to a $0.5 V_{DC}$ offset voltage and supplying a reference voltage that is equal to half the 3V span. This application provides the 00 output code for $V_{IN} = 0.5 V_{DC}$ and the FF output code for $V_{IN} = 3.5 V_{DC}$. In many applications (such as weighing cans on a production line), 14, or even 16-bit converters are often called upon for the needed high levels of resolution. For those reduced-span applications, an 8-bit A/D converter can be used instead—at considerable savings.

A SAMPLED-DATA INPUT

The ADC0801-05 makes use of a sampled-data comparator. Sampled-data circuits cancel the offset voltage, provide essentially temperature-independent performance, and cancel low frequency MOS $1/f$ noise. They do, however, provide some differences in application, since there is an input stray capacitance to ground, as shown in *Figure 1*.

When switch S1 is closed, stray input capacitance, C_{IN} , is charged to the input analog potential, V_{ANALOG} . Note that with a stray capacitance of approximately 12 pF and a 5 k Ω MOS switch resistance, the time constant, τ , is only 60 ns. Thus, C_{IN} becomes charged to the necessary accuracy level (within $\pm 1/4$ LSB) in 6.9τ , or about 0.4 μ s. Since the input switches are operating at one eighth the input clock frequency of 640 kHz, there is ample time for C_{IN} to settle, as comparisons are made only at the end of the clock period. Note that the switch at the (-) analog input discharges the stray capacitance; this event causes input displacement currents to flow.

Input bypass capacitors, when placed directly at the analog inputs, cause full-scale errors, since they average the current which will flow through the source resistance of the analog input signal generator. Input capacitors are not required; but if they are used, a full-scale adjustment will eliminate any system errors.

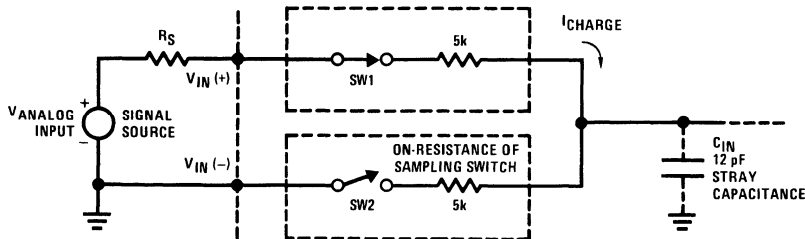


FIGURE 1. Equivalent. Because it has a sampled-data comparator input, the 8-bit ADC0801-05 monolithic analog-to-digital converter looks capacitive to an input signal source. The sampling switches operate at one eighth the rate of the clock frequency.

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The ADC0801-05 monolithic 8-bit CMOS A/D converter can be operated with a wide range of $V_{REF}/2$ voltages that facilitates its use in many different circuit applications. Inexpensive ratiometric transducers, such as potentiometers, can be tied across the converter's 5V supply voltage with the wiper fed directly to the converter's V_{IN}^+ input pin. The $V_{REF}/2$ pin, which will now bias at 2.5V, can be tied to a second potentiometer that is also hooked across the supply voltage to provide a full-scale adjustment.

When the $V_{REF}/2$ is grounded, the converter then functions as a comparator, yielding a digital output of all 1s when V_{IN}^+ is greater than V_{IN}^- , and of all 0s when V_{IN}^+ is less than V_{IN}^- . The $V_{REF}/2$ feature is also useful for low level analog voltage systems where an operational amplifier is normally used to boost the input signal prior to digitization. In a circuit with an analog input voltage of 250 mV maximum, for example, the signal can be fed directly to the A/D device, saving the cost of the amplifier. The $V_{REF}/2$ pin would thus be biased at 125 mV.

CAREFUL GROUNDING

A minor drawback is that this extra analog resolution leaves the circuit more susceptible to noise, and the $V_{REF}/2$ voltage requires a low initial tolerance and must be stable

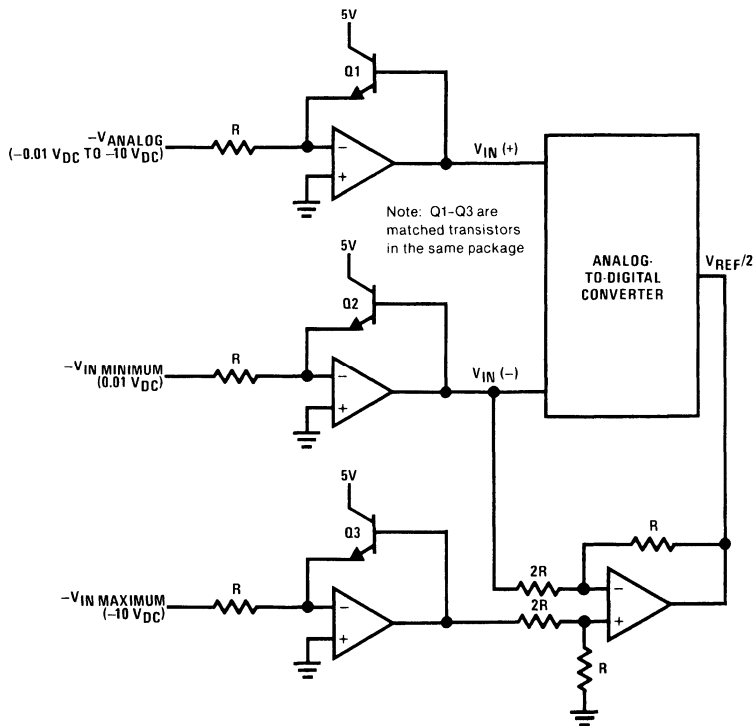
over temperature changes. Grounding problems become more critical and careful grounding is a must.

The ADC0801-05 can also be used as a logarithmic converter to extend the input voltage dynamic range to cover three decades. Three input logging circuits (*Figure 2*) are provided by the NPN transistors in the feedback loops of operational amplifiers. With these at the same temperature (all three on a common chip), there are no thermal problems with this circuit. To keep costs at their lowest, the three transistors in the LM389 audio amplifier IC can be used.

The fourth operational amplifier in *Figure 2* is used to supply the proper $V_{REF}/2$ voltage to the A/D converter. Its DC output voltage is half that of the logarithmically compressed analog input voltage span.

OFFSET ADJUSTING

Yet another application for the ADC0801-05 is in automatically adjusting the offset voltage of an op amp under microprocessor control. This is useful in transducer bridge networks where a pair of amplifiers is normally used to amplify the differential signal. Such an output signal can be fed directly to the A/D converter's inputs without requiring a more costly instrumentation amplifier. The bridge network's arms will thus be biased at approximately $V_{CC}/2$.



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FIGURE 2. Logarithmic. The ADC0801-05 monolithic A/D converter's $V_{REF}/2$ pin allows its use as a three-decade logarithmic circuit. The three NPN transistors in the feedback loops of the operational amplifiers give better accuracy with changing temperature than the diodes normally used.

Figure 3 shows such a circuit, where the microprocessor takes the digital output of the A/D device and automatically adjusts the output voltage of operational amplifier 2. This amplifier is used to isolate the bridge network from the offset adjustment circuit. The INS8255 programmable peripheral interface controls the offset voltage adjustment and analog switches 1 and 2. The CMOS buffer provides ideal analog level swings of either 0V or 5V to the binary resistor network. The binary resistor network extracts and injects a current from and into op amp 3, causing a small voltage drop across R_S . This corrects for offset voltage that is introduced anywhere in the system.

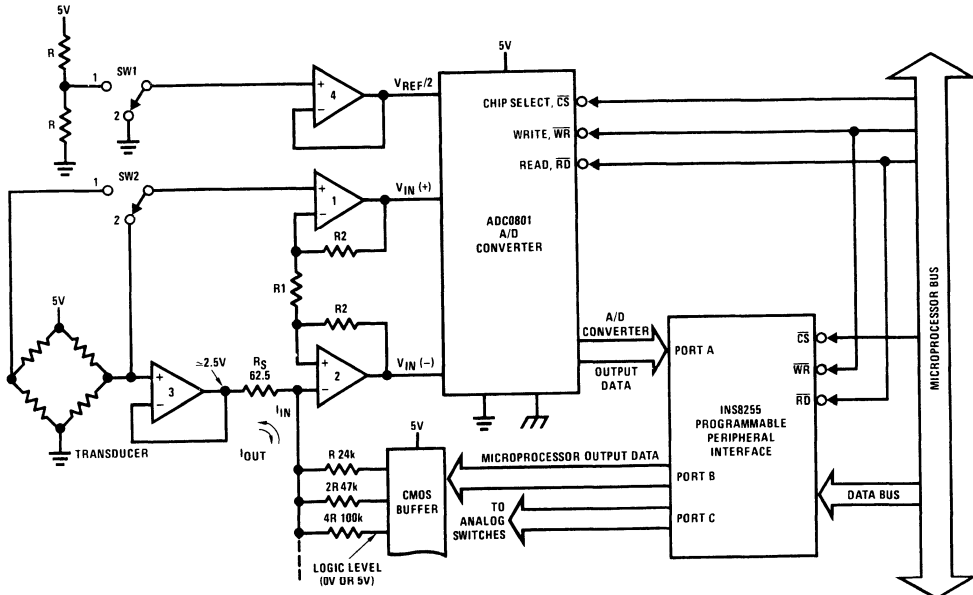
AUTO ADJUSTMENT

Electrically actuated switches 1 and 2 allow the automatic adjustment of the offset voltage. It should be noted that op

amp 1 is referenced to one side of the bridge network in order to cancel any common-mode offset voltage effects.

The A/D converter acts as a high gain comparator because a $0V V_{REF}/2$ is provided by the voltage follower (amplifier 4) and switch 1 circuits. This allows the microprocessor to perform a successive approximation routine to null the offset voltage of the system. Resolution is thus considerably better than the normal $+1LSB$ obtainable with a conventional A/D converter.

The ADC0801-05 combines linear and digital features in an A/D converter that is flexible and easy to tie to microprocessor-based systems. The benefits of a sampled-data comparator and an unusual ladder now make an A/D converter actually easier to fabricate than a digital-to-analog converter.



TL/H/8721-3

FIGURE 3. Automatic. Adjusting the offset voltage of a differential amplifier pair in a transcript bridge network can be done automatically. A microprocessor provides this adjustment through a programmable peripheral interface and a buffer integrated circuit.



CMOS D/A Converters Match Most Microprocessors

National Semiconductor
Application Note 275
Thomas M. Frederiksen
James B. Cecil

With double buffering, 8, 9, and 10-bit multiplying units are useful for microprocessor control of gain and attenuation.

A new family of complementary MOS multiplying digital-to-analog converters has arrived on the scene and promises to make microprocessor interfacing truly universal. The double-buffered MICRO-DAC™ units eliminate many common problems, bridging the way to a host of new applications that include microprocessor-controlled gain, attenuation, and multiplication.

The proliferation of the microprocessor in electronic circuits has brought with it an equal proliferation of microprocessor-compatible D/A converters. Many of these converters, however, have shortcomings in that they often require additional external components to be truly microprocessor-compatible. Furthermore, depending on a converter's resolution and data format, a designer is sometimes forced to adopt additional interfacing circuitry for total microprocessor compatibility. Transient output voltage errors can occur during the updating of a 10-bit D/A converter from an 8-bit microprocessor bus, when the two words are transferred to the converter. Left-justified (fractional binary) and right-justified (positionally weighted binary) D/A converter data formats require different interfacing schemes. All of these problems must be considered in interfacing a microprocessor and a D/A unit.

TWO LEVELS OF BUFFERING

The MICRO-DAC family of multiplying D/A converters consists of 8, 9, and 10-bit accurate units designed to interface directly with the 8080, 8048, 8085, Z-80, and other popular

microprocessors. The converters appear to the microprocessor as a memory location or as an input/output port and require no interfacing logic. Each has two levels of input buffers—an input latch and a register (Figure 1).

The converter's register holds the digital data undergoing conversion, while the input latch is kept busy acquiring new input data. The digital input data is used to update the D/A converter. The double buffering feature allows 10 bits of microprocessor data to be assembled from 2 data bytes. It also prevents the analog output from changing while the digital input word is updated.

Even when used with 16-bit microprocessors, the double buffering feature is necessary for the simultaneous updating of many D/A converters. Double buffering establishes the proper conditions for the next test or lets new system parameters be set up at the same time.

Two groups of MICRO-DAC converters are available. The DAC1000, DAC1001, and DAC1002 are 24-pin units with 10, 9, and 8-bit accuracy levels, respectively. Each contains all of the necessary logic functions for interfacing with right-justified and left-justified microprocessor data. The DAC1006, DAC1007, and DAC1008 20-pin units are designed for left-justified data at accuracy levels of 10, 9, and 8 bits, respectively.

All the members of this family of multiplying D/A converters feature standard chip select (CS) and write (WR) microprocessor control signals. Data on the microprocessor bus can be written into the D/A converter in a standard write cycle.

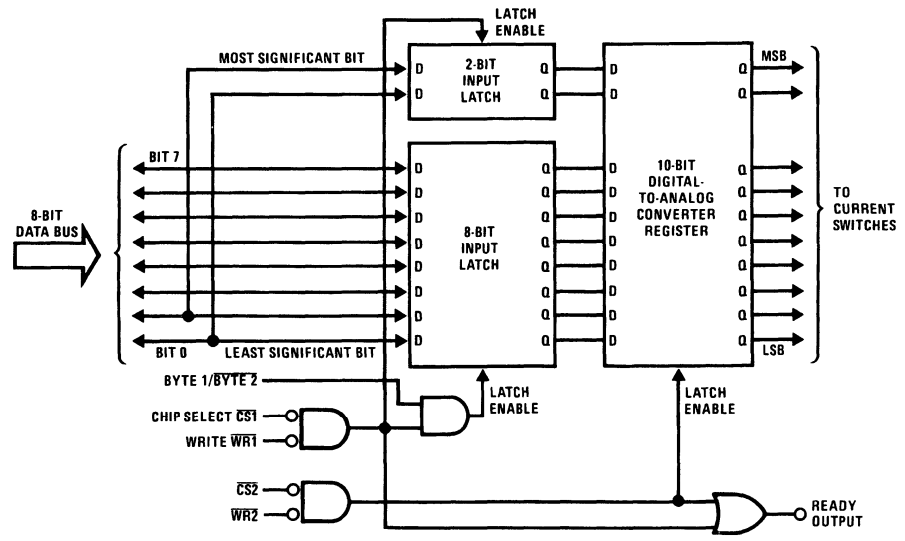


FIGURE 1. Double buffered. The MICRO-DAC family of 8, 9, and 10-bit digital-to-analog converters has two levels of input buffers—an input latch and a register. They are designed to interface with 8080-, 8048, 8085, Z-80, and other popular microprocessors, with no interfacing logic.

TL/H/8715-1

HANDLING THE DIFFERENT DATA FORMATS

Different data formats exist for many D/A converter products, all of which must be readily handled when interfacing with a microprocessor. Left-justified (fractional number $\times V_{REF}$) and right-justified (positional number $\times V_{REF}/1,024$) are the main ones. Initially, converter manufacturers favored a left-justified approach in which the most significant bit was labeled bit 1. Newer converters have changed to the right-justified approach to match the data format of microprocessor data buses. Nevertheless, the left-justified approach is still widely used. As previously mentioned, the MICRO-DAC family can readily handle left- and right-justified data formats with no additional interfacing circuitry.

When a MICRO-DAC converter uses either an 8-bit (two write cycles) or a 16-bit (one write cycle) data bus, all 10 locations of the converter's input latch are enabled on the first write cycle from the microprocessor. Depending on the data format, the next write cycle, if used, overwrites 2 of the 10 locations at the proper data rate.

Digital data is transferred from the input latch to the register internally in one of three ways: automatically when the second write byte occurs; through microprocessor control, which allows the updating of several D/A converters if this is necessary; and through the use of an external strobe.

The converter's CMOS logic levels are made compatible with those of TTL by a special biasing circuit that uses the parasitic NPN bipolar transistor available on a CMOS chip. The bipolar transistor supplies a base-emitter voltage (V_{BE}) that acts as a reference for the converter's digital inputs. It supplies an input threshold voltage of $2 V_{BE}$ that has the same amplitude as that of TTL devices.

Details of the biasing circuit are shown in *Figure 2*. Note that the reference N-channel field-effect transistor, Q1, is tied in a feedback loop so as to have its gate voltage biased at a level of V_{THN} , causing it to conduct the $60 \mu A$ shown in its drain circuit. The three NPN transistors in the loop add a voltage of $3 V_{BE}$ to V_{THN} . The output emitter-follower, Q2, causes a loss of V_{BE} , thus producing a voltage reference

of $2 V_{BE} + V_{THN}$ for use by all of the logic input circuits. Each of the input stages has FETs like Q3, whose source has the digital input applied to it and whose geometry is the same as that of FET Q1. Like Q1, Q3 also has $60 \mu A$ of current feeding its drain. When the logic input voltage equals $2 V_{BE}$, Q3 conducts, thereby pulling the input of a standard CMOS inverter to a low level. This $2 V_{BE}$ threshold continues to be independent of the D/A converter's supply voltage. $2 V_{BE}$ is the logic threshold voltage of standard TTL gates.

ACHIEVING HIGH ACCURACY

The design of the MICRO-DAC's resistor network is simple, even though it provides high levels of converter accuracy. *Figure 3* shows the current switching inverted R-2R ladder used, which consists of passive components.

The operation of the ladder network requires that all of the 2R legs connect to a 0V, or ground, level. This means that the external operational amplifier shown must have a minimal offset voltage. Only 1 mV of offset voltage can introduce a 0.01% linearity error into the converter's operation. Operational amplifiers like National's LM308A series are available with low offset voltages, and they require no zero adjustments.

When zero adjustment of the operational amplifier's offset voltage is required, a $1 k\Omega$ resistor can be temporarily switched in between the converter's I_{OUT1} terminal (which is tied to the amplifier's negative input terminal) and ground. No DC balancing resistance should be used in the operational amplifier's grounded positive input terminal, since it may create errors. The operational amplifier, a BI-FET™ LF356 (made with bipolar and field-effect transistors), has a low input bias current which makes it an ideal choice for use as a current-to-voltage converter. The amplifier's offset voltage should be adjusted with a digital input of all zeros to force I_{OUT1} of the converter to a zero current level. The manually switched-in resistor provides a DC gain of about 15 to the offset voltage and makes the zeroing easier to sense. The converter chip provides the feedback resistor for good initial matching as well as for tracking over temperature.

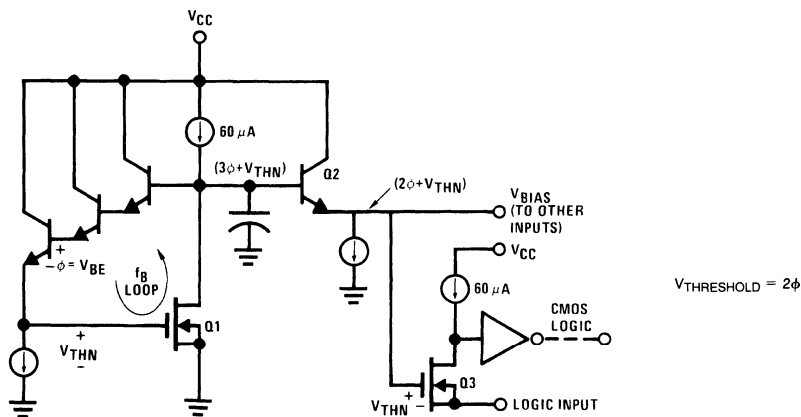


FIGURE 2. Threshold. This basic logic threshold loop provides the biasing for the MICRO-DAC family of MOS D/A converters to interface with TTL voltage levels. This circuit uses the parasitic bipolar structure, which delivers an input threshold of $2 V_{BE}$ to the biasing circuit.

TL/H/8715-2

LOOKING AT THE INSIDE

An examination of the internal details of the single-pole, double-throw current-mode switches employed in the converters shows that the N-channel FETs' gates are driven from the D/A converter's supply voltage. In contrast to a 5V supply, a 15V level reduces the FETs' on-resistances and thereby improves the converter's performance.

MICRO-DAC converters are relatively stable in gain and linearity during variations in the 15V supply voltage. For example, a drop in supply voltage all the way down to 5V results in a gain error of only -0.1%. Even smaller is the change in linearity error for the same supply voltage swing—just -0.005%.

The usefulness of a D/A converter can be determined by the magnitude of the linearity errors resulting from changes in the reference voltage. For applications, like multiplication, that require small values of reference voltage, small linearity errors are essential. In the case of the MICRO-DAC converters, reducing the reference voltage from 10V to 1V results in a worst-case linearity error change of approximately 0.005%.

Figure 4 shows a typical application of a MICRO-DAC as a unipolar voltage output device. This circuit inverts the negative reference voltage to a positive output, with a maximum value of $1,023/1,024$ of the reference voltage multiplied by V_{REF} . The BI-FET operational amplifier used is an LF356 that slews and settles within 3 μ s.

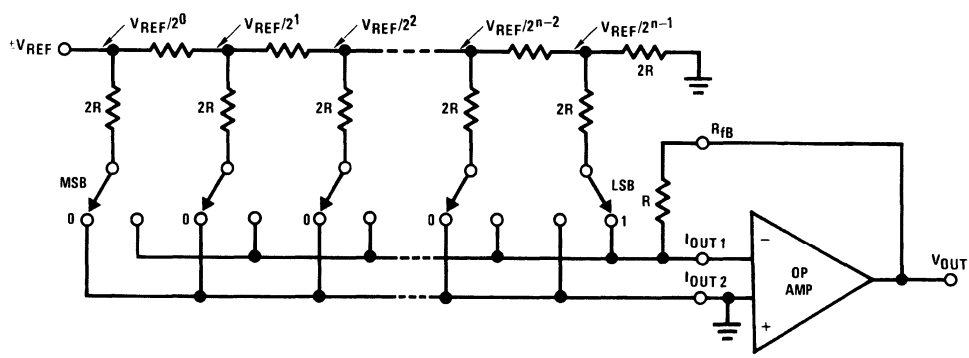
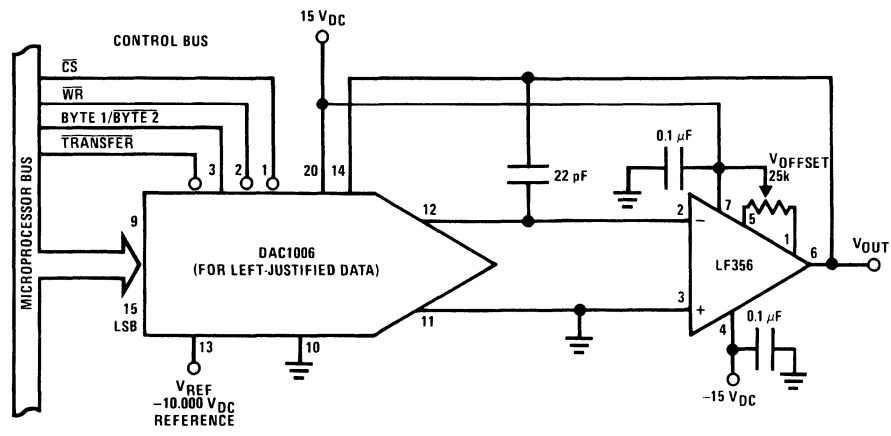


FIGURE 3. Ladder. The current-switching, current-mode R-2R resistor ladder of the MICRO-DAC family of D/A converters is simple, yet provides high levels of converter accuracy. The external operational amplifier is chosen for minimal offset voltage for the least converter linearity error.

TL/H/8715-3



$$0 \leq V_{OUT} \leq 9.990 V_{DC}$$

TL/H/8715-4

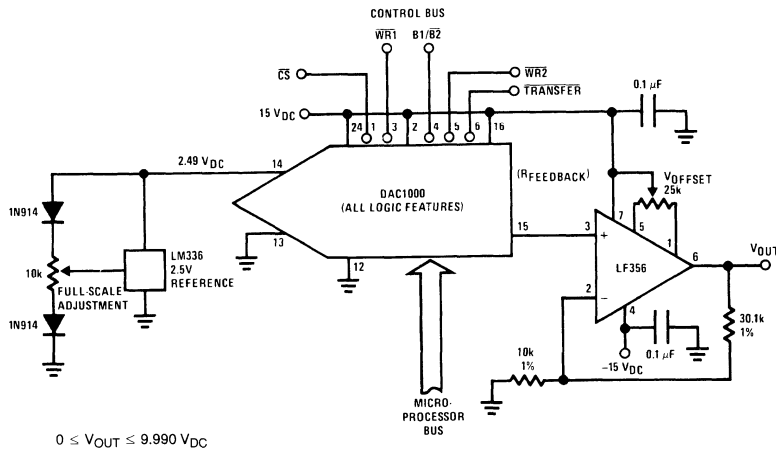
FIGURE 4. Unipolar. In a typical unipolar application, a MICRO-DAC D/A converter inverts the negative reference voltage to a positive one. The positive output is $1,023/1,024$ of the negative reference voltage multiplied by $9.990 V_{DC}$. The output amplifier slews within 3 μ s.

Operating the MICRO-DAC's R-2R resistor ladder in a voltage switching mode as shown in *Figure 5* gives a faster slewing and settling time—1.8 μ s. The ladder is being used backwards. The reference voltage that is derived from the LM336 reference diode is applied to the I_{OUT 1} pin. An output voltage is produced at the converter's pin 15 where the reference voltage was previously located in *Figure 4*. This output voltage ranges from 0 to (1,023/1,024) (2.49 V_{DC}). The LF356 operational amplifier used supplies a gain of a little more than 4 for an overall output voltage ranging from 0 to 1 LSB less than 10V (or 9.990 V_{DC}). The two compensating diodes at the ends of the full-scale adjustment potentiometer on the LM336 reference improve the temperature stability of the reference voltage.

For a bipolar output voltage, the circuit in *Figure 6* may be used. The bipolar output voltage results from adding or subtracting the reference voltage from the converter's output voltage.

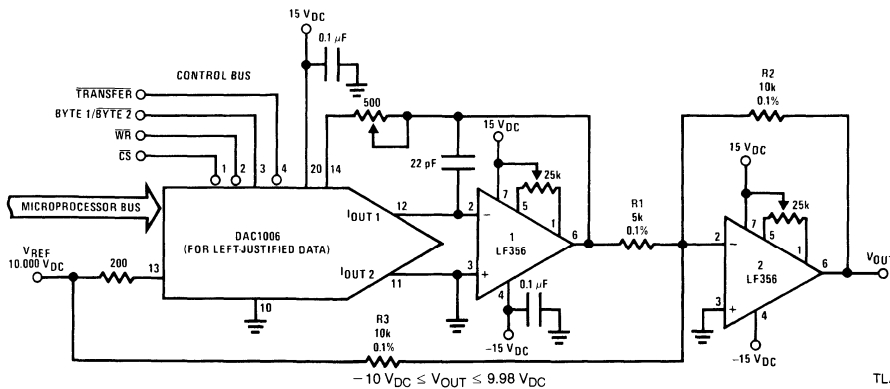
The output of operational amplifier 1 ranges from 0 to $-1,023/1,024 \times V_{REF}$ (or $-9.990 V_{DC}$). This voltage is then applied to operational amplifier 2, where a gain of -2 doubles the voltage range. A $-10 V_{DC}$ offset voltage at the output of operational amplifier 2 is provided by adding the converter's reference voltage to the amplifier's input. Resistors R1, R2, and R3 in the circuit of operational amplifier 2 must stay matched even during temperature changes for the circuit of *Figure 6* in order to work properly.

The bipolar converter of *Figure 6* is adjusted by first entering a digital code composed of all zeros into the D/A converter. Next, the offset potentiometer of operational amplifier 1 is adjusted for a zero amplifier output voltage and then the offset potentiometer of operational amplifier 2 is adjusted for an amplifier output voltage of $-10,000 V_{DC}$. Finally, a digital code of all 1s is applied, and the 500 Ω potentiometer, in series with R_B of the D/A converter, is adjusted for an output voltage of 9.98 V_{DC}. This voltage is $V_{REF} - 1 \text{ LSB}$, where $1 \text{ LSB} = V_{REF}/512$.



TL/H/8715-5

FIGURE 5. Voltage mode. Operating the MICRO-DAC D/A converter's resistor ladder in a voltage-switching mode provides a faster slewing and settling time (1.8 μ s) than that of *Figure 4*. Note that the D/A converter's R-2R ladder is being used backwards.



TL/H/8715-6

FIGURE 6. Bipolar. By adding and subtracting the MICRO-DAC D/A converter's reference voltage from its output voltage, a bipolar output results. For this circuit to work properly, however, resistors R1, R2, and R3 in the circuit of op amp 2 must stay matched during temperature changes.

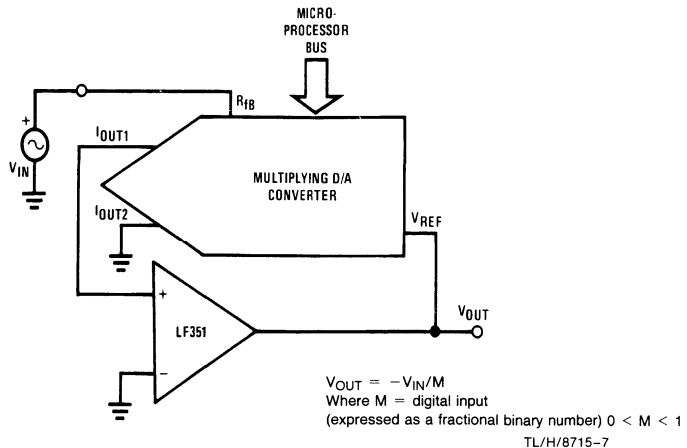


FIGURE 7. Control. A MICRO-DAC D/A converter can be used for microprocessor control of an amplifier circuit. Since the converter has 4-quadrant multiplication capability, AC and DC signals can be handled. The feedback resistors referred to but not shown is in the converter.

USING THE MICROPROCESSOR FOR CONTROL

The MICRO-DAC multiplying D/A converter can be used in a microprocessor-controlled amplifier circuit as the feedback element for the amplifier (Figure 7). Since the converter has 4-quadrant multiplication capability, both AC and DC signals can be handled. The feedback resistor (not shown) is the internal one on the D/A converter's chip.

The D/A converter in Figure 7 automatically provides an output voltage that causes the current from the converter's IOUT1 terminal to the VREF terminal to equal the input current, V_{IN}/R_{FB} . Note that when the microprocessor provides data to the D/A converter with the LSB set to a 1, a relatively large value of the reference voltage is needed to balance the input current. This value corresponds to the maximum gain of $-1,024$. The minimum gain of $-1,024/1,023$ is obtained for a D/A converter digital input of all 1s. In all, 1,023 gain steps are provided.

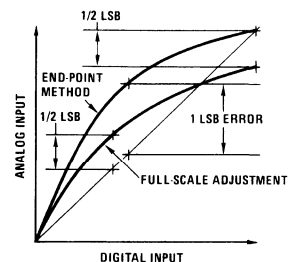
The addition of another amplifier in the converter's IOUT2 leg produces a microprocessor-controlled amplifier and attenuator. Compared with the gain of the circuit that appears in Figure 7, the gain here is noninverted and ranges from 0 to 1,022.

END POINT VS BEST-STRAIGHT-LINE

To maximize their product yields, manufacturers of digital-to-analog converters like to use a best-straight-line linearity guarantee. Unfortunately, this method is based on iteration of the zero and full-scale converter adjustments, so that errors are optimally split and equidistant from a straight line. To the converter user, a best-straight-line specification means that the D/A converter must undergo a sophisticated adjustment procedure for its linearity to be proven. Furthermore, each D/A converter has a different best-straight-line fit, making it necessary to adjust every one of them individually.

Another way to specify converter linearity is by an end-point method. For a current output converter, the offset voltage of the current-to-voltage output amplifier is first adjusted for 0V output. Then the converter is adjusted with a full-scale input digital code to produce a full-scale output voltage. This simple technique ensures that each of the 10-bit unit's 1,024 steps are within the stated linearity specification. Further, a pretrimmed output amplifier can be used to eliminate the zero offset adjustment, leaving only the full-scale adjustment.

The differences between the best-straight-line and end-point specification techniques are shown in the illustration (below), where a D/A converter with an error of 1 least significant bit is shown failing the end-point linearity test. Note that by readjusting the converter's full-scale output, the D/A converter's error is optimally split on either side of the ideal line in a best-straight-line fit, which is a time-consuming procedure, particularly when done on a large number of individual converters. For many an application where the D/A converter is already mounted on a printed circuit board, the end-point adjustment of zero and full-scale is much less time-consuming. Furthermore, this end-point procedure is a more stringent guarantee of converter linearity than the best-straight-line approach. The end-point method is used for D/A converters in the MICRODAC family.



TL/H/8715-8

A New, Low-Cost, Sampled-Data, 10-Bit CMOS A/D Converter

National Semiconductor
Application Note 276
Sing W. Chin



"IF IT'S NOT LOW COST, IT'S NOT CREATIVE"

Cost is the single most important factor in the success of any new product. The current emphasis on digital approaches to build electronic systems and the success of microprocessors have created new, high-volume markets for low cost A/D converters. Without this stimulation in the marketplace, converter products would not have been selected as monolithic components, due to the relatively low volume usage of the traditional products. The challenge today, therefore, is to find new design solutions which will reduce costs of A/Ds without sacrificing the performance specifications.

HOW MANY BITS ARE NEEDED?

The question of how many bits are needed in the A/D converter for a particular system is not always easy to answer. This is further complicated because of the distinction which must first be made between resolution and accuracy. For example, your digital bathroom scale may have graduations which indicate each pound over a range which extends from zero to 300 pounds maximum. This means you are capable of "resolving" one pound over this complete dynamic range or "span." The next question is, "What do I really weigh, say, on my doctor's scale?" You may find that his scale indicates you are actually three pounds heavier than your scale indicates: this is the accuracy problem.

A 10-bit A/D is capable of resolving 2^{10} , or 1024, minimum voltage levels over the range from 0 to V_{REF} volts. To put this into the physical world we live in, this degree of resolution is capable of differentiating each single sheet of paper, which is only 0.004 inches (4 mils) thick in a stack of paper 4 inches high. In any stack of paper up to this maximum limit, a 10-bit A/D could be used in an electronic system which would sound an alarm if a sheet was added to or removed from the stack. (For simplicity, this assumes we have a perfect height transducer and perfect analog signal conditioning circuitry between this transducer and the input to the A/D.)

If the A/D converter has an accuracy of ± 1 least significant bit (LSB), this could be expressed as $\pm 1/1024$ or $\pm 0.1\%$ of full-scale.

10 BITS PRESENTS DESIGN PROBLEM

An A/D converter which provides every possible analog voltage as a tap on a resistor ladder would require 2^{10} , or 1024 resistors. A ladder expansion technique has been previously developed which has greatly reduced the number of resistors. This technique has been used to provide an 8-bit A/D (the ADC0804 family) which uses a theoretical minimum of only 7 resistors. (In practice, extra resistors are typically used to improve matching by making use of unit resistors.)

This 8-bit A/D design was the starting point for developing this 10-bit converter. A new idea, which is key to the 10-bit design, is a novel way to, in effect, use the previous 8-bit circuit four times to increase the resolution to 10 bits[†]. This was achieved by adding 2 MSBs to the 8-bit design. We will first review the 8-bit A/D operation as a basis for understanding the new 10-bit design.

THE BASIC 8-BIT DESIGN

The essential part of the ADC0804 8-bit A/D family is a novel, multiple input, voltage comparator. This circuit allows a new feature for a comparator: multiple, differential voltages can be accepted as simultaneous inputs to the comparator, and each differential input can be weighted by scaling the size of the associated input capacitor. The traditional op amp summing circuit, *Figure 1*, is similar, but accepts single-ended voltage inputs, and first converts each input voltage to an input current by making use of a scaled or weighted input resistor. These input currents are then algebraically summed at the "virtual ground" or summing junction (the (-) input of an op amp which has the (+) input grounded). The current surplus (or deficiency) is supplied through the feedback resistor to produce the output voltage.

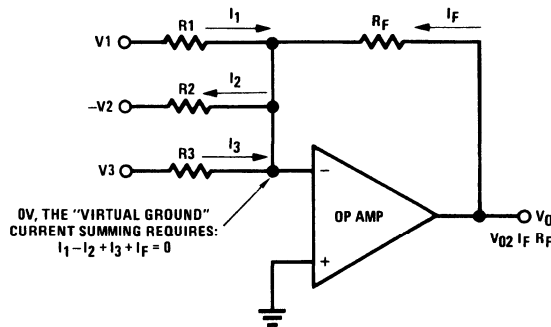


FIGURE 1. The Traditional Op Amp Summing Circuit

TL/H/8716-1

[†]This design concept was proposed and implemented by John Connolly.

A more useful voltage comparator results from a sampled-data approach, which involves switches and capacitors. Now, input voltages are converted to input charges by the use of input capacitors, and the resulting charges are then algebraically added at a "charge summing" node.

A multiple, differential input, sampled-data comparator is shown in *Figure 2* with the switches in the zeroing cycle. The input-output short, which is accomplished with SW5 around the inverting gain block (provided by a logic inverter), causes this stage to bias at a fixed DC voltage. For example, a standard CMOS inverter will bias at approximately one half of the power supply voltage. Notice that at this time the input switches, SW2 and SW4, are precharging the input capacitors with the (-) input voltages of the differential inputs. These input capacitors will serve as storage elements to remember both of the (-) input voltages and the biasing voltage of the gain stage.

These zeroing switches are then opened. The gain stage is now active and will respond to any deviations in the input voltage. An input voltage results when the switches SW1 and SW3 are subsequently both closed. As shown in the figure, $\Delta V1$ is positive, which inputs a charge, Q1, proportional to the value of C1, ($Q1 = \Delta V1C1$). If $\Delta V2$ is negative, a charge, Q2, will be removed from the charge summing node. If the charges Q1 and Q2 are balanced, there is no net change in the input voltage of the inverting gain block.

These switches are dynamically cycled by a clock and the system is zeroed prior to each measuring interval. This is the same operating mode as has been used years ago by the auto-zeroed or chopper-stabilized op amps. A sufficient number of these stages are capacitor-coupled to provide an adequate overall gain for the comparator.

MAKING AN 8-BIT A/D

This sampled-data comparator was made the heart of an 8-bit A/D converter, as shown in *Figure 3*. The comparator now has four differential voltage inputs; one for the analog inputs and three for the DAC. The first 4 MSBs of the 8-bit A/D are supplied by the DAC switches, S1 and S2. As shown, the positions of S1 and S2 correspond to the digital code, "10 00," for the first 4 bits of the 8-bit word. This should input $V_{REF}/2$ to the DAC. Note that S1 is selecting $3/4 V_{REF}$ and S2 is selecting $1/4 V_{REF}$, and these voltages are the first differential pair which is sampled by SW1 and SW2 at the start of a successive approximation search. This provides $(3/4 V_{REF} - 1/4 V_{REF})$ or $1/2 V_{REF}$ as required from the DAC.

The differential input feature of this comparator has allowed an unusual resistor ladder to be used for the DAC. Notice that the top three resistors (each labeled "R") have $1/4 V_{REF}$ across them and the lower resistors (each labeled "R/4") have $1/16 V_{REF}$ across them. The comparator, therefore, allows the increased resolution of the S2 selected voltages to be "fitted into" each section of the upper or S1 selected voltages. In this way, the first 4 bits of this differential DAC, or "DDAC," are realized.

This same 4-bit trick is used again via the left side decoding switches, S3 and S4. These same voltage values provide charge which is reduced in significance by 16:1, making the input capacitor for this section a factor of 16 smaller. This now provides the least significant 4-bit group. The additional capacitor, C, and the lowermost two resistors (labeled "R/8") supply a $1/2$ LSB overall DAC offset voltage. This is used in A/Ds to center the natural $\pm 1/2$ LSB quantization uncertainty of the A/D about the integer LSB values of analog input voltage. (This is $1/2$ LSB voltage is added to the analog input to cause the 00_{HEX} to 01_{HEX} code change of the A/D to occur at any analog input voltage value of only $1/2$ LSB.)

If we are to use this basic 8-bit design for a 10-bit converter, we must make these 8 bits the least significant of the 10-bit data word. This can easily be done by again scaling the capacitor sizes. Further, 2 additional MSBs must be added: here is where another trick comes in.

A NOVEL WAY OF ADDING 2 MSBs

The 2 MSBs of the DAC will control 2^2 , or 4, voltages. If these are chosen as V_{REF} , ground, $1/3 V_{REF}$ and $2/3 V_{REF}$ we have an unusually beneficial situation. Notice that the differential voltage input feature of the sampled-data comparator allows picking up the two intermediate voltages ($1/3$ and $2/3 V_{REF}$) from a resistor divider with only one tap, as shown in *Figure 4*. These odd voltage values ($1/3$ and $2/3 V_{REF}$) from this 2 MSB DAC are "cleaned up" simply by scaling the size of the input capacitor which is used for this DAC section by a factor of $3/4$. This will, therefore, provide the $1/4 V_{REF}$ increments 0, $1/4 V_{REF}$, $2/4 V_{REF}$ and $3/4 V_{REF}$, which are necessary for the 2 MSBs. Now the basic 8-bit circuit can be used a total of 4 times, with each referenced to one of these $1/4 V_{REF}$ values. This will cover the analog input voltage range of 0 to V_{REF} with 10 bits of resolution, as shown in *Figure 5*.

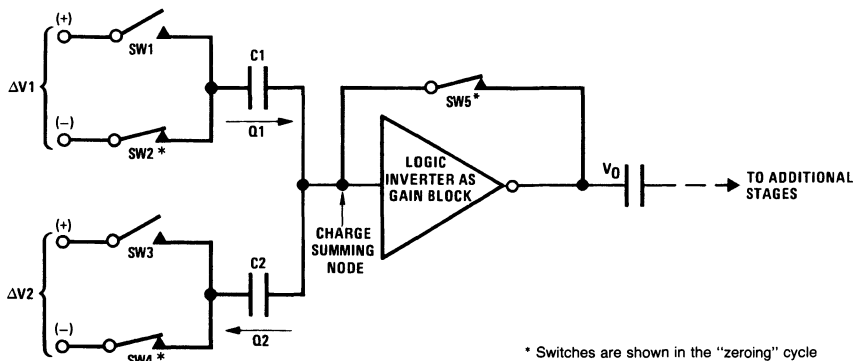


FIGURE 2. A Multiple, Differential Input Sampled-Data Comparator or Charge Summing Circuit

TL/H/8716-2

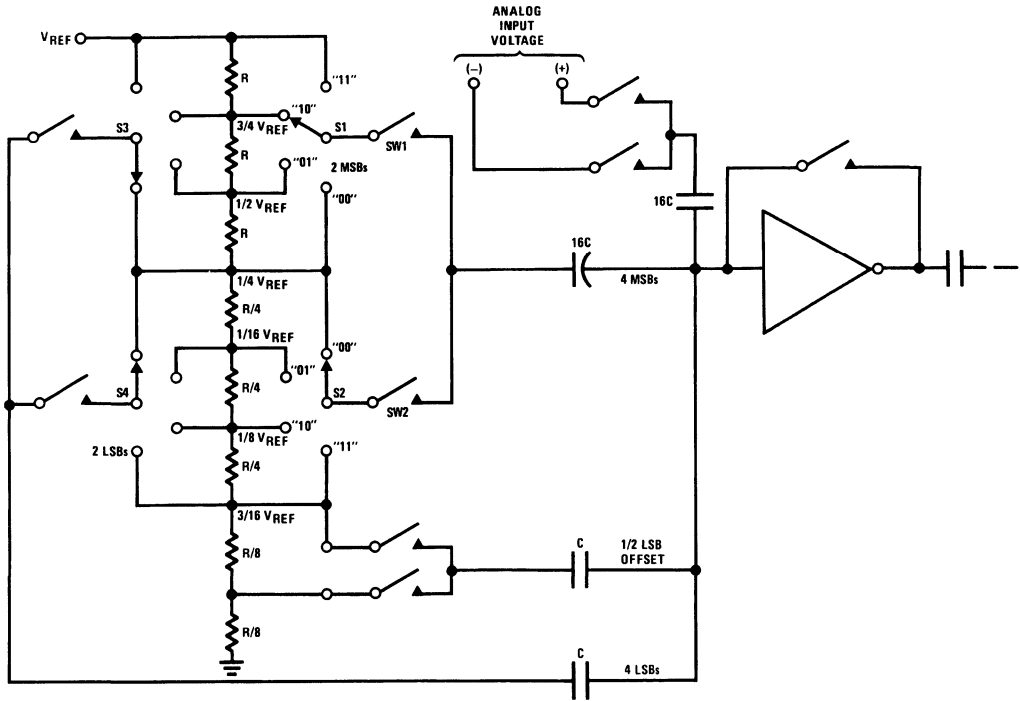
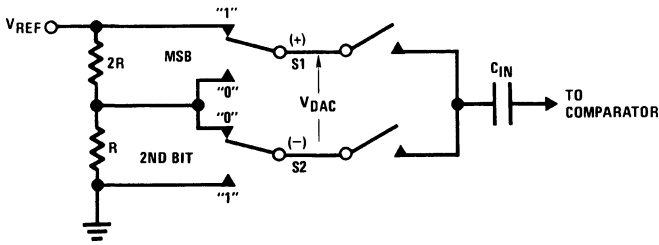


FIGURE 3. Basic DAC Ladder of 8-Bit A/D Converter

TL/H/8716-3



S1 (MSB)	S2 (2nd Bit)	V _{DAC}
0	0	0
0	1	1/3 V _{REF}
1	0	2/3 V _{REF}
1	1	V _{REF}

TL/H/8716-4

FIGURE 4. Providing the 2 MSBs of a 10-Bit A/D

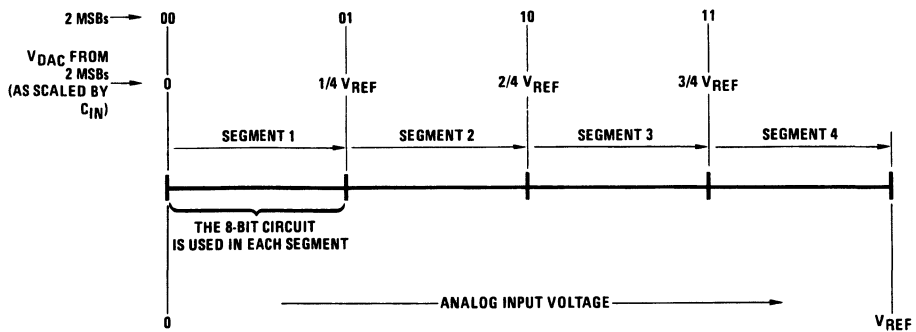


FIGURE 5. How the 2 MSBs Extend the 8-Bit Circuit to 10 Bits

TL/H/8716-5

This 2 resistor ladder will produce linearity errors in only 2 of the segments of the overall A/D transfer characteristic, because there will be no errors in the first segment (2 MSBs = 0), because V_{DAC} for this code is 0V. Similarly, if we assume that the input capacitors ratio properly, there will be no linearity errors in the last segment, because the full V_{REF} is sampled (then is weighed to produce $\frac{3}{4} V_{REF}$ as compared to the analog input voltage, via C_{IN}). Any mismatch between the C_{IN} of the analog differential input voltage and the C_{IN} of the DACs will cause a full-scale error, not a linearity error.

The two end segments are therefore both free of linearity errors and an additional benefit is that any error in the exact value of the tap voltage on a 2 resistor divider has the natural characteristic that the error is the same magnitude on the $\frac{1}{3} V_{REF}$ and $\frac{2}{3} V_{REF}$ voltages, and is simply of opposite sign. Thus, a linearity trim must provide a single magnitude of correcting charge, then this same charge is introduced into the comparator summing mode in one polarity for the "01" 2 MSB code, and then the opposite polarity for the "10" code (a correcting charge is not used for the "00" or "11" codes).

THE ADC1001, A 10-BIT A/D

In keeping with the similarity to the previous 8-bit A/D, a 10-bit product was designed to fit in the same 20 pin (0.3" wide) package and to use the same pinouts. Now a customer can easily interchange from an 8 to a 10-bit A/D. This allows for a range of performance variation in his end products while using the same PC board.

The problem of getting the 10-bit output of the A/D onto an 8-bit data bus is handled by reading two 8-bit bytes. The

data is left-justified and transferred, most significant byte first. This allows a single read cycle to pick up a valid 8-bit representation (the 8 MSBs) and can save time if this is all the resolution that is required on a particular analog channel. A second read cycle will pick up the 2 LSBs of the 10-bit data word. The 6 LSB positions are set to zero in this second byte. An internal byte counter keeps track of the byte sequencing so multiple, double-read cycles can be made, if desired.

The problem of properly biasing a 5 V_{DC} reference circuit when operating from only a single 5 V_{DC} power supply voltage was handled on the 8-bit part by reducing the operating reference voltage for the internal DAC to only 2.5 V_{DC} . This can be designed to still provide a 5V full-scale for the A/D by simply doubling the sizes of all of the DAC input capacitors to the comparator. This technique was also used for this 10-bit product. The reference voltage can also be further reduced in magnitude to increase the analog resolution over a reduced analog input voltage span, if desired.

A basic diagram of the DAC and the comparator input section of the 10-bit A/D are shown in Figure 6. A simplified schematic representation has been used for the 8 LSB section. This has been shown in more detail in Figure 3 without the V_{REF} reduction to $V_{REF}/2$.

To understand the scaling shown for the input capacitors, keep in mind that it is the input charge which is balanced. This means that a maximum differential analog input voltage of 5V would produce an input charge of $5 \times 32C$ or $160C$

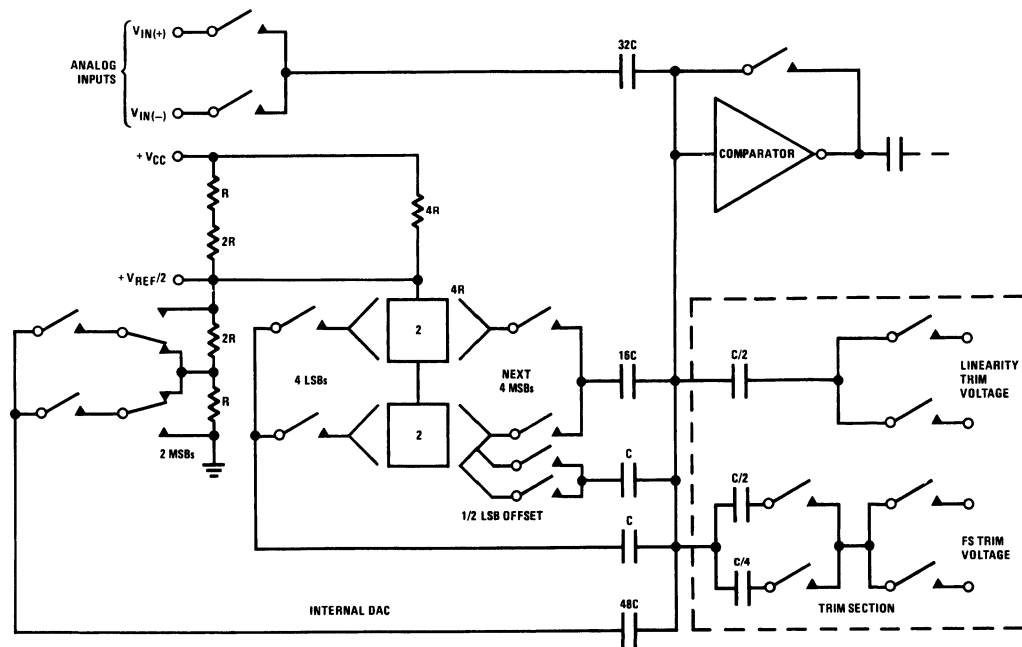


FIGURE 6. The DAC and Comparator Input Section

TL/H/8716-6

coulombs. If the DAC were forced to a "11 0000 0000" or 300_{HEX} code, the voltage, which is output from the 2 MSB section, would be $V_{REF}/2$. This is converted to an input charge via the 48C capacitor, so this charge, Q300_{HEX}, becomes:

$$Q_{300_{HEX}} = \frac{V_{REF}}{2} \times 48C$$

and as $V_{REF}/2 = 2.5V$
then

$$Q_{300_{HEX}} = 2.5 (48C)$$

or

$$Q_{300_{HEX}} = 120C$$

which ratios to the analog full-scale charge, Q_{AFS} as

$$\frac{Q_{300_{HEX}}}{Q_{AFS}} = \frac{120C}{160C} = \frac{3}{4} FS$$

which is the proper weight for the 300_{HEX} code.

Similarly, the "00 1000 0000" or 080_{HEX} code should require $\frac{1}{8} (V_{REF})$ at the analog input (neglecting the effects of the $\frac{1}{2}$ LSB offset voltage shift) to balance. This is the output of the 8 LSB section with a binary code of "1000 0000" input to this DAC section. The charge from the analog input, Q_A, which corresponds to an analog input voltage of $\frac{1}{8} V_{REF}$, is given by:

$$Q_A = \frac{1}{8} (V_{REF}) (32C)$$

The output voltage of the 8-bit DAC section for 080_{HEX} code is $\frac{1}{2} (V_{REF})/2$, so the charge input by this DAC, Q_{DAC}, is given by

$$Q_{DAC} = \frac{1}{2} \left(\frac{V_{REF}}{2} \right) (16C),$$

and this ratios to the analog input charge, Q_{A1}, as

$$\frac{Q_{DAC}}{Q_A} = \frac{\frac{1}{2} (V_{REF}/2) (16C)}{\frac{1}{8} (V_{REF}) (32C)} = 1$$

as expected. The 4 LSB grouping of this 8-bit DAC uses an

input capacitor $\frac{1}{16}$ smaller in value to properly reduce the significance of the last 4 bits.

FULL-SCALE TRIM

Full-scale (or "gain") errors are trimmed by introducing an additional correcting charge into the summing node of the comparator. This is done in steps; for example, no full-scale correction is used on the first $\frac{1}{4}$ of the analog input voltage range (near zero). The next range receives $\frac{1}{3}$ of the total FS correcting charge, then $\frac{2}{3}$, and finally the full charge is introduced in the last section. This sequencing of the FS trim is achieved by dynamically altering the input capacitance from no capacitance to C/2, to C/4, and finally to 3C/4. This is the reason for the extra input capacitor and the added switches, which are shown in the FS trim section of *Figure 6*.

APPLICATIONS

The standard applications of the 8-bit ADC0804 series* can now easily be extended to 10 bits by simply plugging in the new ADC1001 10-bit part. In addition, a 24 pin product (ADC1021) is also available, which brings all 10 bits out for a 16-bit data bus application.

The zero offsetting (by introducing a DC shifting voltage into the $V_{IN(-)}$ pin) can be used to accommodate analog input voltages which do not swing to ground. The $V_{REF}/2$ input voltage can also be reduced to accommodate a reduced span of analog input voltages. Finally, system designers can use the same PC board for either an 8-bit or a 10-bit product to take advantage of the standard pinouts used for these A/D converters.

CONCLUSIONS

The multiple, input, sampled-data voltage comparator allows many benefits in both the design and application flexibility of monolithic A/D converters. This revolutionary concept has reduced the die size of A/Ds, allows many product benefits, and appears to be the optimum solution for the realization of a low cost, high performance, monolithic A/D converter line.

*For further details see data sheet.

The New MICRO-DAC™ Product Line for Microprocessor Systems

National Semiconductor
Application Note 277
James B. Cecil



A second generation of the popular MDAC (or multiplying DAC) is now available which has been designed to provide an easy interface to microprocessor systems. These new MICRO-DAC products are low power drain CMOS converters, which typically require only 0.5 mA supply current (2 mA max) and draw only approximately 600 μ A from a 10 V_{DC} reference supply.

The basic problems which are inherent in bipolar designs are not present in this CMOS product. CMOS devices have nearly infinite current gain, therefore there are no β or α errors in the design. Also, there is no analogous term to offset voltage in these products, rather, an ON CMOS switch is nothing more than a small resistor which can be controlled by device geometry. To avoid the temperature coefficient and piezoresistive problems of diffused resistors, silicon chromium thin-film resistors are used.

These resistors track within 1 ppm/°C, which insures excellent temperature tracking characteristics. Also, the feedback resistor, which is needed with an external op amp, is provided on the chip, which insures a low temperature coefficient of the gain or full-scale reading of the DAC.

Bipolar designs in the 10-bit region can have a power dissipation of 300 mW. Unless extreme care is taken to insure an almost perfect thermal die layout, it is very possible to have a 1°C temperature gradient on the die. If a diffused resistor ladder were to be used in the presence of this gradi-

ent, it will cause a 0.15% error. This means that all of the allowable error in a 10-bit DAC will be used up due to this thermal gradient. From this, it is obvious that the CMOS DAC, with its combination of a low temperature coefficient thin-film resistor ladder and an on-chip power dissipation of 30 mW max, will overcome one of the major problems in bipolar designs.

DATA FORMATS AND DATA BUFFERS

From the digital viewpoint, a DAC seems little more than a *write only memory* where the information in the memory is made available as the analog output voltage. Problems arise concerning data formatting. Is the data to be left-justified (fractional binary) or right-justified (positionally weighted binary)? Also, updating a 10-bit DAC from an 8-bit bus can cause transient output voltage errors until the complete new word has been transferred.

The data format options are shown in *Figure 1*. Early converter manufacturers favored fractional binary, and this has caused the MSB to be labeled as "Bit 1" on DAC products. As may be expected, this convention has been changed in the new converter products to match the notation of the bits on the data bus of μ Ps. People supplying converter products still favor the fractional binary format, but it appears that the user groups are approximately split on the question of which to use.

MSB									LSB
1	0	1	0	1	0	1	0	2	0
2^{-1}	2^{-2}	2^{-3}	2^{-4}	2^{-5}	2^{-6}	2^{-7}	2^{-8}	2^{-9}	2^{-10}
1/2	1/4	1/8	1/16	1/32	1/64	1/128	1/256	1/512	1/1024

$$V_{OUT} = (\text{fractional binary number}) \times V_{REF}$$

a) Left-Justified Data

MSB									LSB
1	0	1	0	1	0	1	0	1	0
2^9	2^8	2^7	2^6	2^5	2^4	2^3	2^2	2^1	2^0
512	256	128	64	32	16	8	4	2	1

$$V_{OUT} = (\text{positionally weighted binary number}) \times V_{LSB}$$

$$\text{where } V_{LSB} = V_{REF}/1024$$

b) Right-Justified Data

FIGURE 1. Data Formats for a 10-Bit Converter

Both of these problems go away with the addition of flexible input digital data buffers (latches) which allow complete applications flexibility (Figure 2). For example, with two levels of input buffers (double buffering), the DAC Register has the job of holding the current digital data which is being converted, and the other, the Input Latch, is then available to acquire new digital data which will eventually be used to update the DAC. This allows 10 bits to be assembled with two data bytes from the μ P and prevents the transient output error at updating time. Further, even with 16-bit μ Ps, double buffering is necessary to allow many DACs to be updated simultaneously. This is useful to establish the proper conditions for a next test, or to allow new system parameters to be set up at the same time.

Data formatting is handled by providing flexibility in the way the digital data is entered into the Input Latch. To allow operation with either an 8-bit (two write cycles) or a 16-bit (one write cycle) data bus, all 10 locations of the Input Latch are enabled on the first write cycle from the μ P. Then, depending on the data format, the next write cycle, if used, will overwrite two of these locations with the proper data.

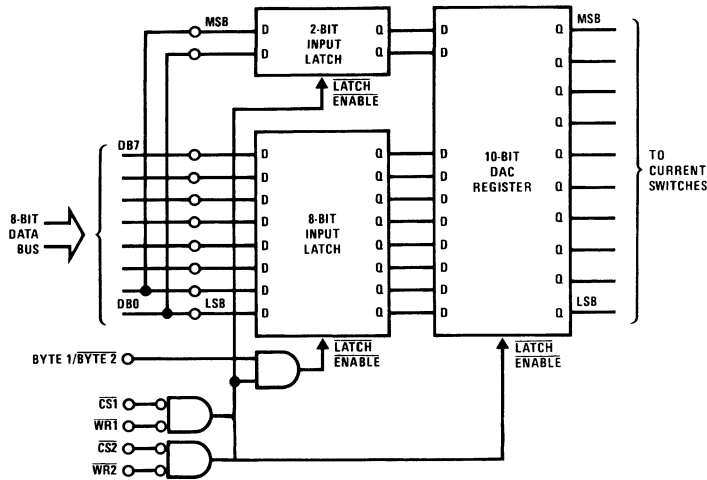


FIGURE 2. Double-Buffering the Digital Input Data

TL/H/8717-1

Part #	Accuracy (Bits)	Pin	Description
DAC1000	10	24	Has All Logic Features
DAC1001	9		
DAC1002	8		
DAC1006	10	20	For Left-Justified Data
DAC1007	9		
DAC1008	8		

FIGURE 3. MICRO-DAC Product Options

Two product options are offered, as shown in the matrix of Figure 3. Each of the 2 functional options is offered in accuracies of 8, 9 or 10 bits. The 20 pin 0.3" wide packages are used for fixed left-justified data format. The 24 pin part is pin programmable for either right- or left-justified data.

All of these options make use of the standard μ P control signals, such as \overline{CS} and \overline{WR} , and the data on the bus can be read by the converter in a standard write cycle. As expected, the internal CMOS logic is faster for higher supply voltages, and this effect on the write strobe width is shown in Figure 4.

The internal transfer of the digital data from the Input Latch to the DAC Register can be controlled in three ways: 1) automatic transfer when the second byte occurs, 2) use the μ P to control the transfer—this signal can update several DACs, if desired, or 3) use an external strobe to cause the transfer.

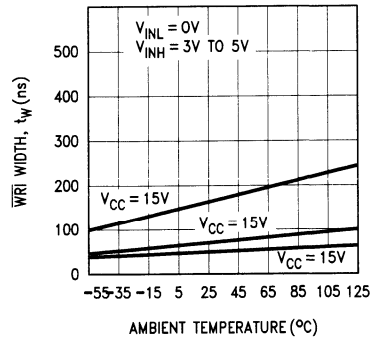


FIGURE 4. Write Strobe as a Function of the V_{CC} Supply Voltage and Temperature

TL/H/8717-2

MEETING T²L INPUT VOLTAGE SPECS WITH CMOS

Logic compatibility is aided by having the CMOS logic inputs meet T²L voltage level specs. A special biasing circuit makes use of the parasitic NPN bipolar transistors which are available on the CMOS chip (Figure 5). These bipolar devices will supply base-emitter voltage, V_{BE} , references for the digital inputs. By using this circuit, these CMOS MICRO-DAC products have the same input voltage threshold, $2V_{BE}$, as exists with standard T²L!

The details of this bias referencing circuit are shown in Figure 6. Notice that the reference N-channel transistor, Q1, is tied in a feedback loop, which forces it to conduct the $60\ \mu\text{A}$ which is supplied to its drain. The gate voltage of the transistor thus biases at V_N , the voltage which is necessary for Q1 to conduct the $60\ \mu\text{A}$. The three NPN transistors add $3V_{BE}$ to this voltage. The output emitter-follower, Q2, causes a loss of $1V_{BE}$ and produces a voltage reference of

$2V_{BE} + V_N$ to be used by all of the logic input circuits. One of these input stages, Q3, is also shown on this figure. Note that the digital input is applied to the source of Q3. This transistor has the same geometry as Q1, and also has a $60\ \mu\text{A}$ current source feeding its drain. Due to device matching, Q3 will therefore conduct when the logic input voltage is equal to $2V_{BE}$, and this is the logic threshold voltage of standard T²L logic gates. The variation of this logic threshold with supply voltage and temperature is shown in Figure 7. This input circuitry may surprise a new user because here is a CMOS part which outputs $60\ \mu\text{A}$ of current at the digital input leads when pulled to the low voltage state!

ON THE ANALOG SIDE

Conceptually, it is easiest to think of DACs which use binary weighted resistors. Unfortunately, the large resistance ratios which result have limited this design approach to 4-bit converters where the ratio is 16 to 1.

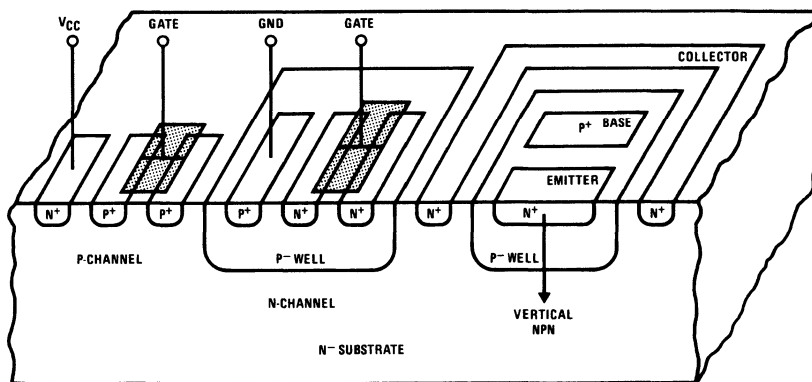


FIGURE 5. A Simplified Wafer Cross Section Showing the CMOS FETs and the NPN Bipolar Transistor

TL/H/8717-3

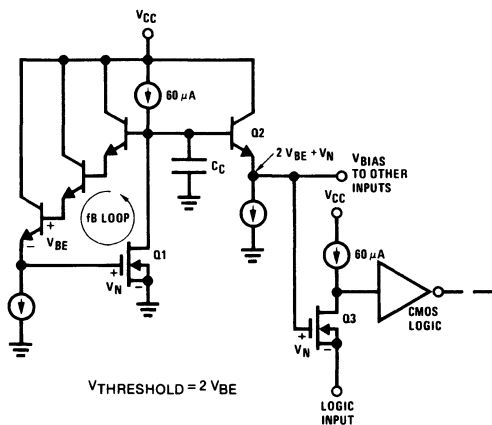


FIGURE 6. Basic Logic Threshold Loop

TL/H/8717-4

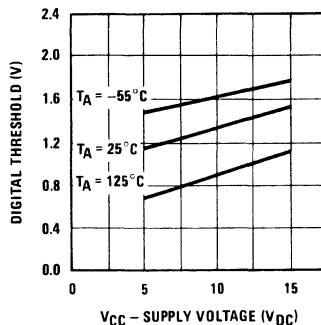


FIGURE 7. Digital Input Threshold vs Supply Voltage

TL/H/8717-5

The R-2R resistor ladder is an old trick to keep the resistors always in a 2:1 ratio, independent of the resolution of the converter. Three variations on the use of these ladders exist which depend on whether voltages or currents are being switched, and whether the output from the ladder is a current or a voltage. The current-switching, current-mode, R-2R ladder is used in the MICRO-DAC products and is shown in Figure 8. This is the heart of the analog section of the DAC and, as can be seen, it consists of all passive components. This inherent simplicity is the strong point of this design approach. The main DAC design problem is to provide a relatively straightforward function—but to do it with a very high accuracy!

Proper operation of the ladder requires that all of the 2R legs always go to exactly 0 V_{DC} (ground). Therefore, offset voltage, V_{OS}, of the external op amp cannot be tolerated, as every millivolt of V_{OS} will introduce 0.01% of added linearity error. At first this seems unusually sensitive, until it becomes clear that 1 mV is 0.01% of the 10V reference!

High resolution converters of high accuracy require attention to every detail in an application to achieve the available performance which is inherent in the part.

Also note that no "DC balancing" resistance should be used in the grounded positive input lead of the op amp, Figure 9. This resistance and the input current of the op amp can also create errors. The low input biasing current of the BI-FET™ op amps makes these ideal for use in DAC current-to-voltage applications. The V_{OS} of the op amp should be adjusted with a digital input of all zeros to force I_{OUT1} = 0 mA. A 1 kΩ resistor can be temporarily connected from the inverting input to ground (Figure 9) to provide a DC gain of approximately 15 to the V_{OS} of the op amp and make the zeroing easier to sense. Note also that the feedback resistor for the op amp is provided on the chip and should always be used. This guarantees both a good initial matching and this resistor will match the R-2R ladder over temperature changes.

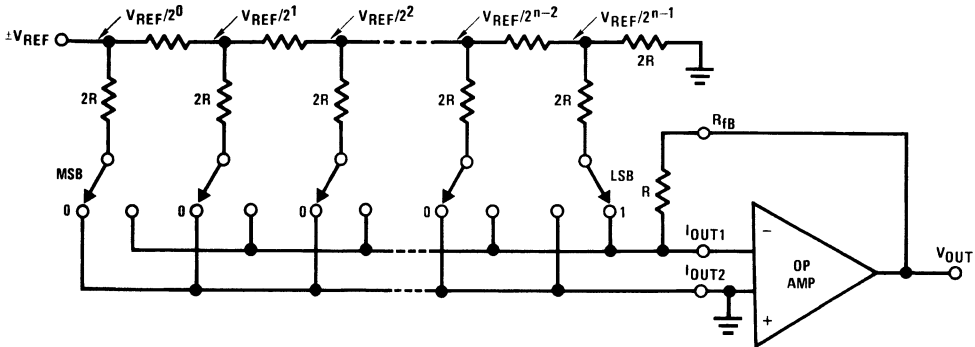


FIGURE 8. The Current Switching—Current Mode R-2R Ladder of the MICRO-DAC Products

TL/H/8717-6

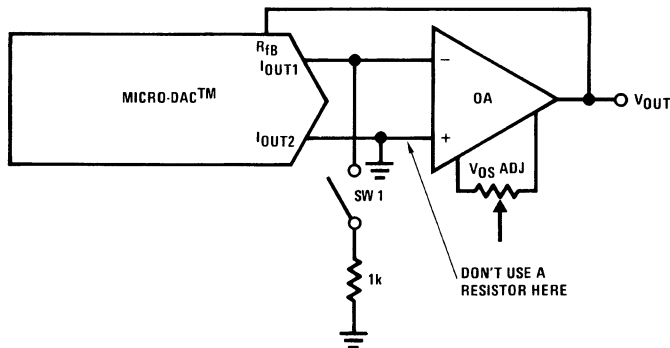


FIGURE 9. Adjusting the V_{OS} of the Op Amp

TL/H/8717-7

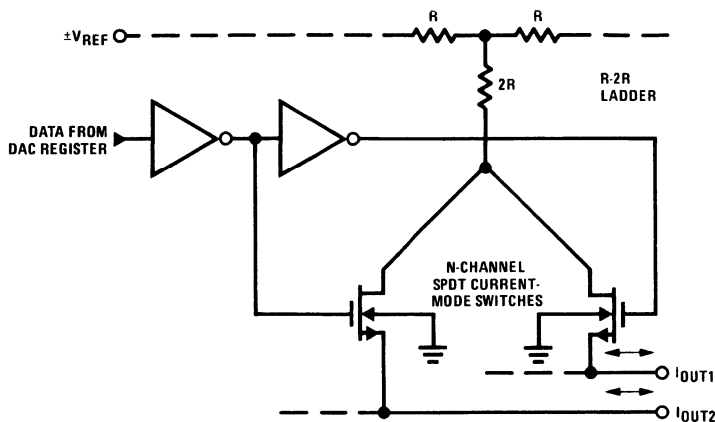
The internal details of the SPDT current-mode switches are shown in *Figure 10*. The N-channel transistors are driven by the V_{CC} supply voltage which is used for the part. Operation at $15 V_{DC}$ reduces the switch ON resistance as compared to the use of a $5 V_{DC}$ supply and, therefore, improves the performance of the DAC. The change in gain and linearity errors as a function of the supply voltage are shown in *Figure 11*. These curves are normalized to the performance with a $15 V_{DC}$ power supply and show the degradation as the supply voltage is reduced.

The usefulness of a DAC can be determined by noting the linearity errors which result as the magnitude of the reference voltage is reduced. This is important for multiplication applications and other uses which require small values of reference voltage. In the case of the MICRO-DAC converters, reducing the reference voltage from 10V to 1V results in a linearity error change of approximately 0.005%.

END POINT GUARANTEE VS BEST-STRAIGHT-LINE

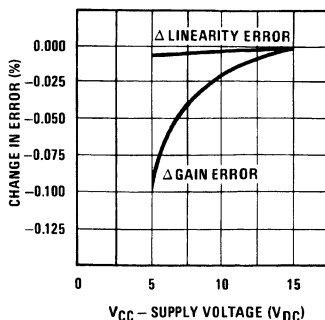
Suppliers of DACs like to use a Best-Fit Straight-Line linearity guarantee to increase yields. Unfortunately, this technique is based upon iterating the zero and the full-scale adjustments to optimally split the errors to be equidistant from a straight line. To the user, this means that each DAC has to go through a rather sophisticated adjustment procedure to home in on this best approximation—which is different for each part.

The alternative specification is called an End Point Spec. This means that after a standard zeroing of the V_{OS} of the op amp (the DAC itself doesn't require a zero adjustment, so a pre-trimmed low V_{OS} op amp can eliminate this adjustment) and a standard full-scale adjustment, the linearity of each of the 1024 steps is within spec! This is a large benefit to the DAC user.



TL/H/8717-8

FIGURE 10. The Basic DAC Circuit



TL/H/8717-9

FIGURE 11. Effects of Supply Voltage on Linearity and Gain Error

The differences between these specification techniques are shown in *Figure 12*. A DAC with an error of 1 LSB and failing the end point test is shown in *Figure 12*. Notice that by readjusting the full-scale, the error of this DAC can be optimally split to be symmetrically located about a Best-Fit Straight-Line. This search for the optimum end point readjustments has to be done by the user for each individual DAC. The end point spec allows standard zero and full-scale adjustment procedures to be used in PC board assembly, and no time-consuming searching or special readjusting techniques need to be used. Further, it can be seen that the end point spec is a more stringent requirement on the linearity of the DAC.

SUMMARY

The CMOS current-switching DACs have evolved from the unbuffered MDACs to the μP compatible double-buffered MICRO-DAC products. Many non-DAC applications have been generated for the MDACs, and we now have the new possibility of μP controlled gain, attenuators and multipliers—all of which easily interface to a μP system. These new low cost monolithic DACs will open up many new applications in the modern electronic systems.

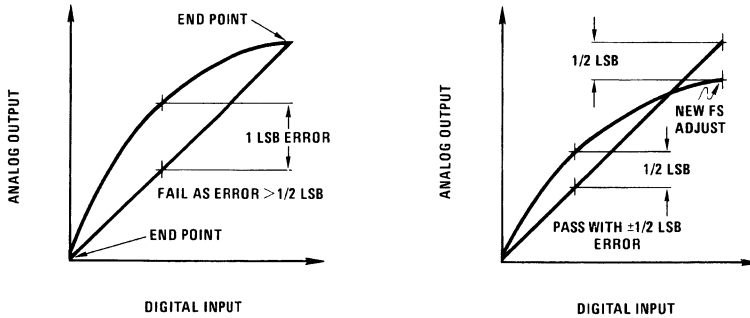


FIGURE 12. Best-Straight-Line vs End Points Specs

TL/H/8717-10

Designing with a New Super Fast Dual Norton Amplifier

National Semiconductor
Application Note 278
Timothy T. Regan



WHY ANOTHER NORTON AMPLIFIER?

The current differencing Norton amplifier has been widely applied over the last 5 years because of the versatility and availability of quad Norton amplifiers (the LM3900). These low cost quads are found today in a wide variety of analog systems, but primarily in medium frequency and single supply AC applications. Today, a brand new dual current differencing amplifier, the LM359, offers spectacular speed improvements which can be used in circuits operating well beyond the video frequencies.

How the speed is improved: The speed improvement of the new Norton amplifier is due to the cascode circuit (*Figure 1*). Cascode circuits are used in high frequency single-ended amplifier designs because there is no Miller effect on the collector-to-base capacitance of the input transistor. Also, there is no collector-to-emitter parasitic feedback in the common base configured transistor, Q2, so the high frequency signal appearing at the output of the cascode does not reflect back into the input. Furthermore, note that band-limiting PNP transistors are eliminated from the signal path; here PNPs are used only for collector loads, so not only is high speed maintained, but high gain is also obtained without additional amplification stages.

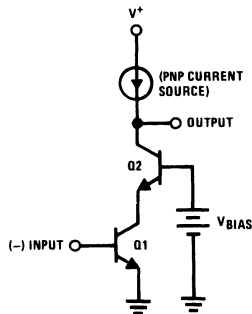


FIGURE 1. Basic Cascode Circuit

TL/H/7490-1

Adding a mirror to get differential inputs: To make the high frequency single-ended amplifier more versatile differential inputs should be provided. An easy way is to add a current mirror across the negative (inverting) input terminal (*Figure 2*). This method provides current differencing, as the current entering the non-inverting input is extracted from the inverting input current. The LM359 is then a current differencing, as opposed to a voltage differencing, op amp.

The programmable features extend versatility: An additional feature of the LM359 is the programmability of its speed, its input impedance, and its output current sinking capability for line driver applications and for control of overall power consumption (*Figure 3*). An internal compensation capacitor is adequate compensation for all inverting applications where the gain is 10 or higher. An additional compensation capacitor can be added externally to reduce undesired bandwidth or to fit any particular application, as will be discussed later. The following sections illustrate some new design ideas using this fast Norton amplifier.

A NEW HIGH FREQUENCY ACTIVE FILTER STRUCTURE

Multiple op amp active filter building blocks are very popular because of their low sensitivities and their tunability. The basic element of such a filter is the inverting integrator. Usually two inverting integrators are cascaded and a third inverter allows closing the overall loop with the proper phase. This is the idea behind the state variable and bi-quad filter structures which today are fully available in low cost hybrid forms.

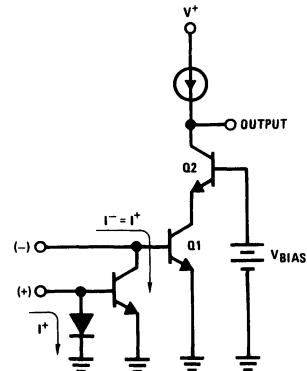


FIGURE 2. Adding a Current Mirror to Provide Current Differencing Inputs

TL/H/7490-2

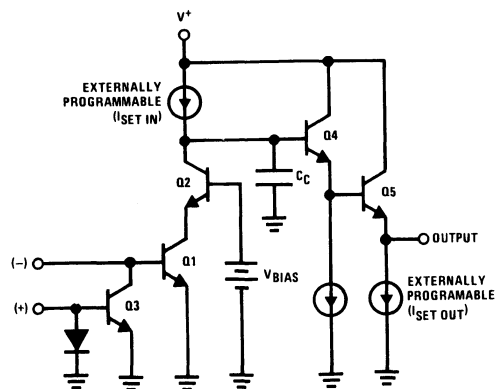


FIGURE 3. A Simplified Schematic of the LM359, a High Speed, Current Differencing Amplifier. The Input, Output and Speed Characteristics are Externally Programmable.

TL/H/7490-3

The op amp count in these filters could be reduced by one (allowing use of a dual op amp instead of 3 op amps or a quad) if a true non-inverting integrator could be built with a single op amp. Unfortunately, this cannot be done with standard op amps but is a trivial task with current differencing amplifiers (Figure 4). Combining a non-inverting integrator with an inverting one, a new high frequency and low sensitivity active filter building block can be made (Figure 5). Table I shows the 3 particular filter structures, together with

their design equations, which are derived from Figure 5. The frequency compensation for the 2 amplifiers is asymmetric to optimize performance. Also, since the LM359 is a wide bandwidth amplifier, high frequency circuit layout is strongly recommended. The circuit works with a single supply, and the output DC biasing of each filter type is provided with 2 resistors, R1 and Rb, which should be chosen according to Table II.

TABLE I. Analysis and Design Equations

Type	V _{O1}	V _{O2}	C _i	R _{i2}	R _{i1}	f _o	Q _o	f _z (Notch)	H _o (LP)	H _o (BP)	H _o (HP)
I	BP	LP	O	R _{i2}	∞	$\frac{1}{2\pi RC}$	$\frac{R_Q}{R}$	-	$\frac{R}{R_{i2}}$	$\frac{R_Q}{R_{i2}}$	-
II	HP	BP	C _i	∞	∞	$\frac{1}{2\pi RC}$	$\frac{R_Q}{R}$	-	-	$\frac{R_Q C_i}{RC}$	$\frac{C_i}{C}$
III	Notch or Band-Reject	-	C _i	∞	R _{i1}	$\frac{1}{2\pi RC}$	$\frac{R_Q}{R}$	$\frac{1}{2\pi R R_i C_i}$	-	-	$\frac{C_i}{C}$ as f → ∞ $\frac{R}{R_1}$ as f → 0

TABLE II. DC Biasing Equations for V_{O1} (DC) ≈ V_{O2} (DC) ≈ V⁺/2

Type I	$\frac{2V_{IN}(DC)}{V^+ (R_{i2})} + \frac{1}{R} + \frac{1}{R_Q} = \frac{2}{R_b}; R_1 = 2R$
Type II	$\frac{1}{R} + \frac{1}{R_Q} = \frac{2}{R_b}; R_1 = 2R$
Type III	$\frac{1}{R} + \frac{1}{R_Q} = \frac{2}{R_b}; \frac{1}{R_1} = \frac{V_{IN}(DC)}{V^+ (R_{i1})} + \frac{1}{2R}$

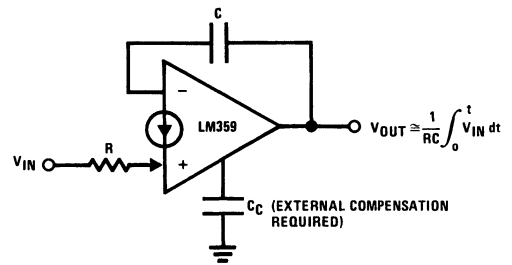


FIGURE 4. A True Non-Inverting Integrator

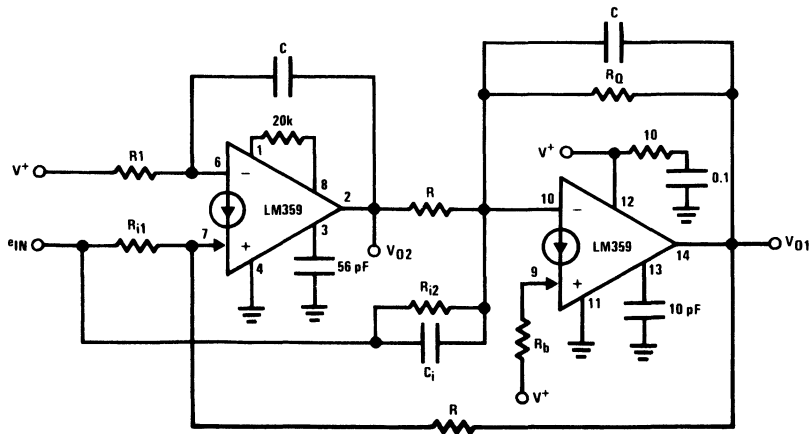


Table I and Table II relate to Figure 5

FIGURE 5. High Performance 2 Amplifier Bi-Quad Filter. Half of the LM359 Acts as a Non-Inverting Integrator and the Other Half Acts as an Inverting One. No Extra Inversion is Necessary to Provide Proper Phase.

The operating range of an active filter can be estimated by comparing its Q_0 , center frequency product ($f_0 \times Q_0$), with the gain bandwidth product (GBW) of its active elements. The $f_0 \times Q_0$ should be less than the active element GBW by a factor of at least 20; a higher factor will yield less sensitive filters. For instance, with a 5 MHz op amp, the $f_0 \times Q_0$ product of the filter should not exceed 250 kHz, and in reality should be even less. The filters tested with the LM359 could extend their $f_0 \times Q_0$ product up to 2 MHz.

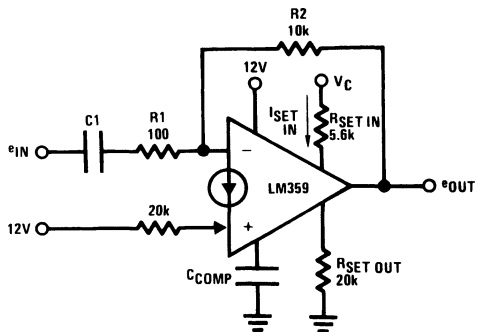
VOLTAGE-CONTROLLED LOW PASS FILTER

A most unique feature of the LM359 is that it provides the user with complete control of its frequency response over a very wide range. The combination of both programmable input stage current and external compensation capability is the key to this flexibility.

One of the most simple, yet illustrative, examples of the usefulness of this capability is the voltage-controlled low pass filter shown in Figure 6. The corner frequency of this filter is determined by the closed loop corner frequency of the inverting, gain of 100 amplifier. This frequency is directly controlled by the frequency of the dominant pole of the amplifier's open loop response, which can be approximated by the expression:

$$f_p \approx \frac{3 I_{SET IN}}{2 \pi C_{COMP} A_{VOL} V_T}$$

where A_{VOL} is the amplifier's DC open loop gain, V_T is equal to KT/q or 0.026V at room temperature, $I_{SET IN}$ is the input stage programming current, and C_{COMP} is the total compensation capacitance.



TL/H/7490-6

FIGURE 6. Voltage-Controlled Low Pass Filter. Minimum Input Frequency is Determined by C1 and R1.

The closed loop corner frequency, which, as stated is also the corner frequency of the filter, is:

$$f_c = \beta \cdot GBW = \beta \cdot A_{VOL} \cdot f_p$$

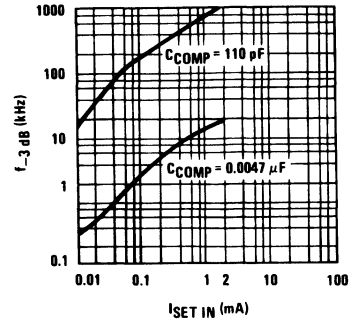
where β is the feedback factor, $R1/(R1 + R2)$, and a single pole open loop frequency response is assumed. Combining these two expressions, the corner frequency is:

$$f_c = \frac{3 I_{SET IN} \cdot \beta}{2 \pi C_{COMP} V_T}$$

The simplest method to dynamically control f_c is to vary $I_{SET IN}$ through a control voltage, V_C , where:

$$I_{SET IN} = \frac{V_C - V_{BE}}{R_{SET IN} + 500\Omega}$$

In this manner, C_{COMP} should be chosen for the highest desired corner frequency at maximum $I_{SET IN}$. Two curves illustrating the dependence of the corner frequency on $I_{SET IN}$ for two different compensation capacitors are shown in Figure 7.



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FIGURE 7. Amplifier Closed Loop Corner Frequency vs ISET IN

It should be noted that as the compensation capacitor is increased, or $I_{SET IN}$ is decreased, the maximum slew rate of the amplifier is decreased. To prevent slew rate induced distortion of sinusoidal input signals, the following restriction applies:

$$\text{Slew rate max} = \frac{3 I_{SET IN}}{C_{COMP}} \geq \omega V_o \text{ peak,}$$

where $V_o \text{ peak}$ is the peak output voltage of the filter and ω is $2 \pi f_{IN}$, where f_{IN} is the signal frequency. The output voltage for signal frequencies less than the corner frequency of the filter (within the passband) should then be restricted to:

$$V_o \text{ peak} \leq \frac{V_T}{\beta}$$

VIDEO AMPLIFIERS

The basic principle behind the design of the LM359 is to provide amplification of high frequency signals with the ease of using standard operational amplifiers. The most obvious application area for this amplifier is in the video area where a fair amount of gain is required at frequencies much higher than monolithic op amps can provide.

A specific application is the amplification or buffering of a composite video signal for a distributed monitor system.

Figure 8 shows a typical connection for a non-inverting video amplifier whose signal source may be either detected video from a receiver, or possibly a camera signal. The output stage of the LM359 can be programmed, as shown, to drive a terminated 75Ω cable to 4 Vp-p for use as a video line driver. For color signals, the differential phase error and differential gain error at 3.58 MHz are desirably low, as noted in Table III.

TABLE III. Typical Video Amplifier Performance

$A_V = 20$ dB	} at 3.58 MHz
-3 dB Bandwidth \rightarrow 2.5 Hz to 25 MHz	
Differential Phase Error $< 1^\circ$	
Differential Gain Error $< 2\%$	
Amplifier Output Swing = 4 Vp-p Max	

For general purpose wideband amplifiers, the availability of two amplifiers in a single package allows cascading two gain stages to achieve very high gain bandwidth products as shown in Figure 9.

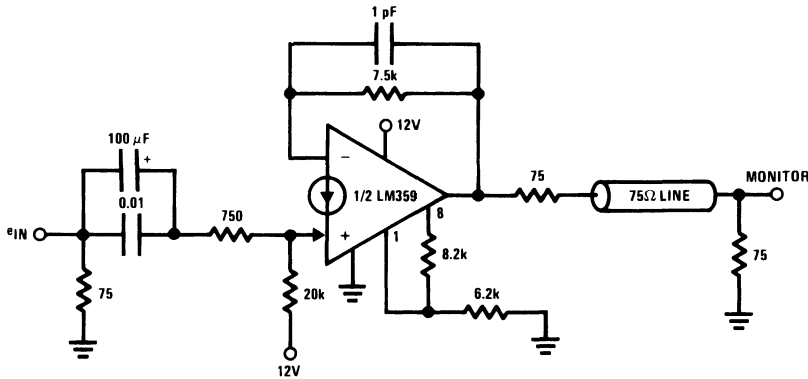
DISC AND MAGNETIC TAPE MEMORY SENSING

In digital data recovery from a magnetic storage medium, such as a disc or magnetic tape, there exists a need for high gain bandwidth amplifiers to convert the low level voltage transients from the output of the playback head (caused by a magnetic flux reversal on the tape or disc) to digital

pulses that can be processed by data separating or decoding circuitry. The two amplifiers in a single LM359 package can be combined in a variety of ways to provide the basic blocks of a playback channel.

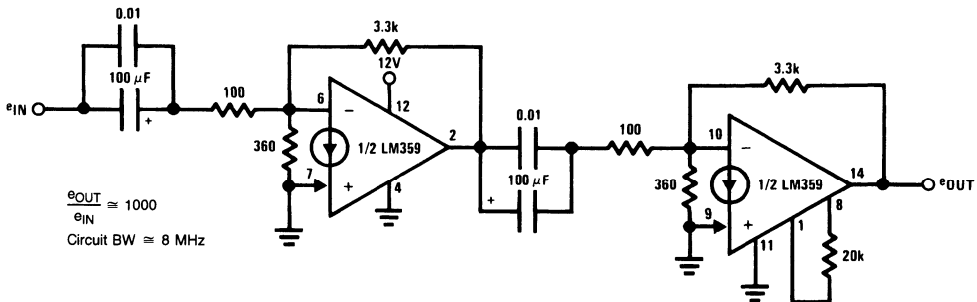
- a) For very high bit rates and low level signals they can be cascaded to optimize overall gain bandwidth product, as already shown in Figure 9.
- b) For single-ended playback signals (non center-tapped head), one amplifier can be used as a gain stage and the other as a differentiating stage to convert recovered signal peaks into bi-directional zero crossing signals, and then properly drive a comparator with regard to direction of flux changes on the disc or tape; this simplifies decoding of phase-encoded data.
- c) For differential playback signals (center-tapped head), one amplifier can be used to provide gain for each output signal individually to retain the differential signal, or a single amplifier difference amp can perform a differential to single-ended conversion and the other amplifier can perform differentiation of the single-ended signal. For multi-channel, parallel recorded data, the overall component count of the playback system can be minimized by using one amplifier of the LM359 per channel.

Combining gain with constant delay filtering: Another important application of the LM359 in data recovery systems is that of filtering. It is most desirable to prevent high frequency noise spikes from being coupled through the sensing stage causing erroneous readings, but the low



TL/H/7490-8

FIGURE 8. A Typical Application of this Fast Norton Amplifier as a High Performance Video Amplifier Driving a 75Ω Line



$\frac{e_{OUT}}{e_{IN}} \approx 1000$
Circuit BW ≈ 8 MHz

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FIGURE 9. General Purpose, High Gain, Wideband Amplifiers Can Be Obtained by Cascading the 2 Norton Amplifiers Available on a Single Chip

pass filter used must not induce time delays to valid data signals which will be decoded by their time relationship to each other. This immediately implies a constant group delay low pass filter or a Bessel filter approximation which, if implemented with active components, can also provide signal gain. Figure 10 shows a fourth order, 250 kHz, gain of 100 Bessel filter. Here, because of the low Q_0 requirements of the Bessel filter, a simple (Sallen-Key) filter structure has been chosen over the previously discussed higher performance structures. Note, however, that constant group delay filtering and amplification are performed with a single package.

A HANDLE ON INPUT NOISE

The programmability of the amplifier's input stage current and the ability to "shut off" the non-inverting input current

mirror allows significant improvements of the noise characteristics. For an inverting application where the non-inverting input would only be used for DC biasing purposes, an alternate biasing scheme, the nV_{BE} biasing, can be used, as shown in Figure 11. This allows "shutting off" the input current mirror which, in itself, will reduce the input noise by a factor of two.

In addition, the input stage programming current can be increased to further reduce the noise voltage at the expense of an increase in input noise current and low frequency $1/f$ noise, which are not a problem in low input impedance, wideband amplifiers. The typical effect on noise vs input stage current is illustrated in Figure 12.

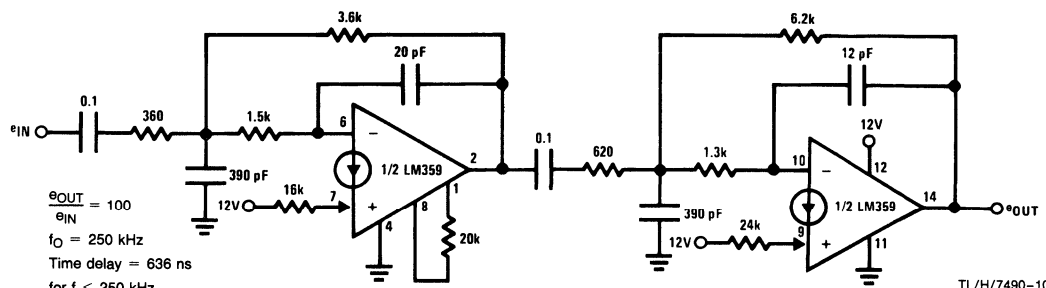


FIGURE 10. A Fourth Order, 250 kHz Bessel Filter for Data Recovery Systems. The Filtering Function is Done with a Single Package.

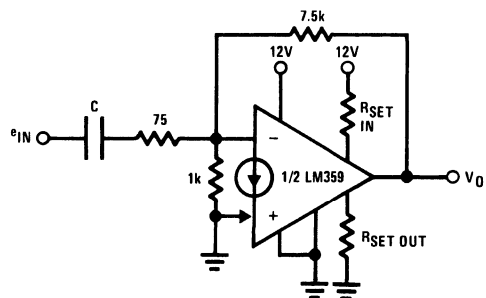
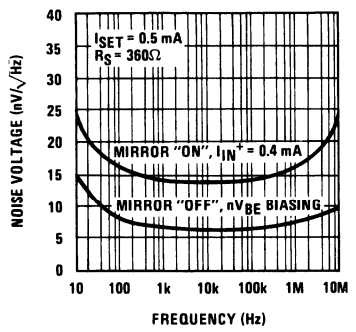
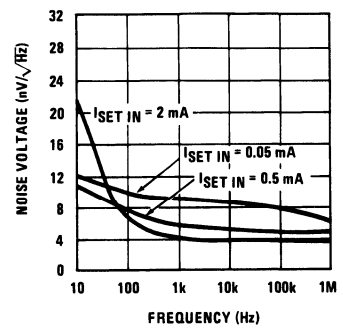


FIGURE 11. nV_{BE} Biasing Can Reduce Input Noise Voltage



a) Effect of "Shutting Off" the Input Mirror



b) Noise Performance of Figure 11

FIGURE 12. Programmability Provides a Handle on Input Noise

MAKING A FAST JFET INPUT OP AMP

The current mirror input stage of the LM359 can be used as an active load for a differential JFET stage to form a super fast op amp (Figure 13). This circuit combines the high frequency performance and programmability of the LM359 with the high input impedance and low bias currents of a discrete JFET input stage. External compensation of the LM359 is generally required to accommodate any additional phase shift of the input stage, and the "pole-splitting" configuration shown in Table IV. Note that this op amp should be mainly used for very high speed, single supply AC coupled circuits. This is because the op amp DC input offset voltage depends mainly on the matching of 2 discrete JFETs.

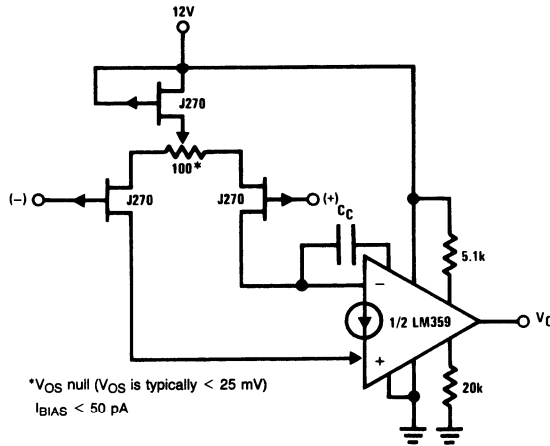
TABLE IV. Typical Amplifier Performance

A _v	BW	S _r	C _c
1	40 MHz	60 V/μs	51 pF
10	24 MHz	130 V/μs	5 pF
100	4.5 MHz	150 V/μs	2 pF

A HIGH COMMON-MODE INPUT VOLTAGE DIFFERENCE AMPLIFIER

An inherent feature of a current differencing input stage is that the voltages from which the input currents are derived are limited only by the maximum input current (or mirror current) of the amplifier and the size of the input resistors. An application that takes advantage of this is a high common-mode voltage difference amplifier (Figure 14). In this circuit, the LM359 will amplify the difference in voltage between inputs V1 and V2, but both inputs can be riding on a common-mode level as high as approximately 250 V_{DC} without exceeding the maximum mirror current of 10 mA.

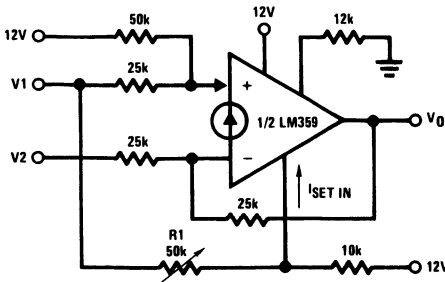
The addition of resistor R1 in Figure 14 allows an adjustment of the common-mode rejection ratio by adjusting the inverting input bias current, I_{SET IN}. This bias current error is most significant at lower common-mode input voltage levels. By making the bias current directly proportional to the input level, a 20 dB CMRR improvement is possible by adjusting R1 for maximum CMRR at the maximum input common-mode voltage.



*V_{OS} null (V_{OS} is typically < 25 mV)
|I_{BIAS} < 50 pA

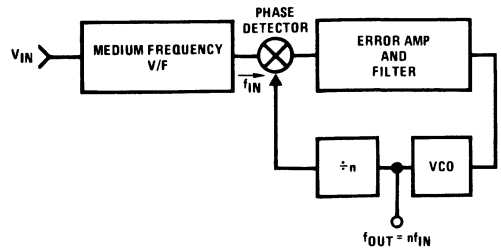
TL/H/7490-13

FIGURE 13. Combining the Norton Amplifier with Discrete P-Channel JFETs to Make a Fast Voltage Mode Op Amp



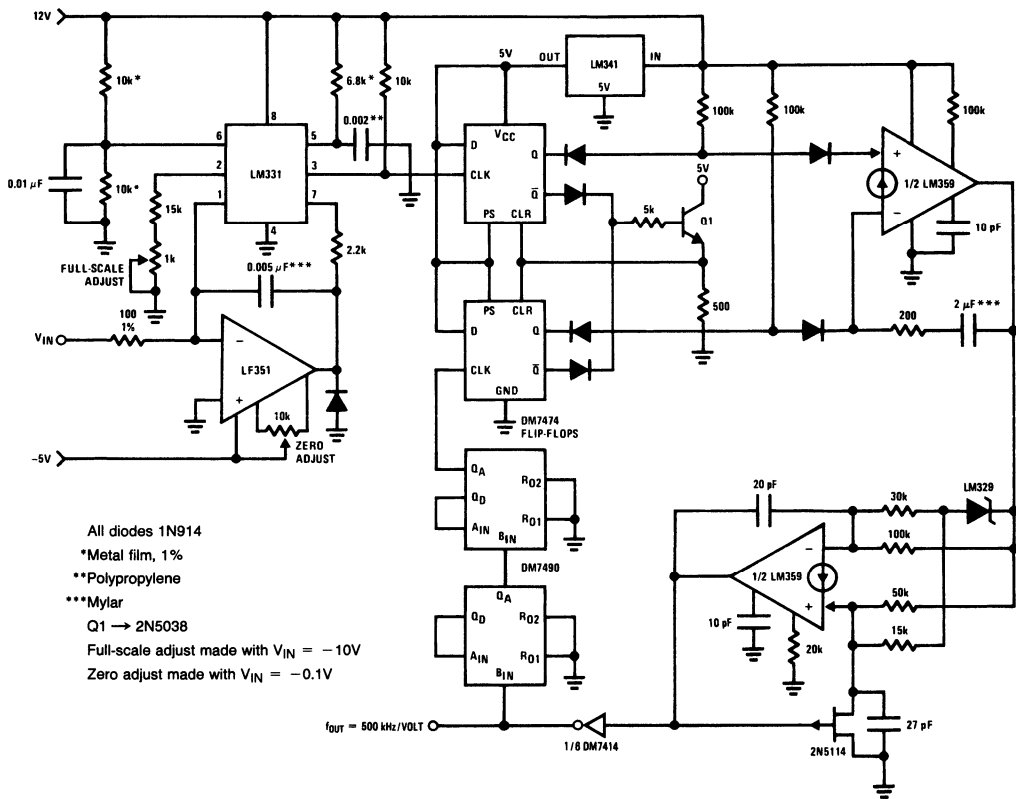
TL/H/7490-14

FIGURE 14. A High Input Common-Mode Voltage Difference Amplifier



TL/H/7490-15

FIGURE 15. Using a Fast PLL to Make a High Frequency, Ultra Linear V/F



All diodes 1N914
 *Metal film, 1%
 **Polypropylene
 ***Mylar
 Q1 → 2N5038
 Full-scale adjust made with $V_{IN} = -10V$
 Zero adjust made with $V_{IN} = -0.1V$

TL/H/7490-17

FIGURE 16. Complete Schematic of an Ultra Linear, Two Decade (50 kHz → 5 MHz) VCO

BUILDING A FAST AND ULTRA LINEAR V/F CONVERTER

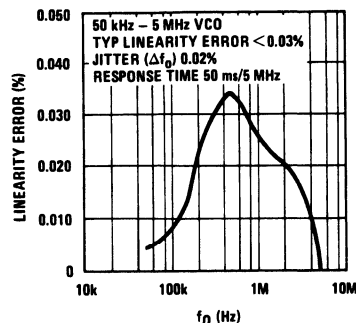
Linear and fast voltage-to-frequency (V/F) converters are very difficult to build, especially when standard V/F design techniques are used. A solution to this problem is the use of a fast phase locked loop (PLL) which is driven by a medium frequency and ultra linear V/F IC (the LM331), Figure 15. This high frequency operation is obtained via a frequency divider inserted into the loop, and the linearity of the overall circuit closely approximates the linearity of the medium frequency input V/F. The high frequency, quasi linear VCO, and the error amplifier of the PLL are designed by using the 2 sections of the LM359. The output frequency of the VCO, which is also the output of the system, is divided by 100 and is compared with the output of the driving V/F via a digital phase detector. The overall circuit is shown in Figure 16. Following a zero and a full-scale adjust, the V/F works well over 2 decades of frequency and its non-linearity is below 0.03%, as shown in Figure 17.

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Fredericksen, T.M.; Howard, W.M.; Sleeth, R.S., "The LM3900—A New Current-Differencing Quad of \pm Input Amplifiers" AN-72, National Semiconductor Corporation.

Nortronics Design Digest on Digital Recording, Application Factors to Consider for Magnetic Heads, 1976.

Pease, R.A., "New Phase-Locked-Loops Have Advantages as Frequency to Voltage Converters (and more)" AN-210, National Semiconductor Corporation.



TL/H/7490-16

FIGURE 17. Typical Performance

A/D Converters Easily Interface with 70 Series Microprocessors

National Semiconductor
Application Note 280
Jim Chiang



Abstract: This application note describes techniques for interfacing parallel I/O and serial I/O 8-bit A/D converters to the INS8070 series of microprocessors. A detailed hardware and software interface example is provided for each type of A/D.

As examples, the INS8073 is used to interface with the parallel I/O ADC0804, and the INS8072 is used with the serial I/O ADC0833.

INTRODUCTION

The INS8070 series of microprocessors is designed for compact, low cost control, data acquisition, and processing applications. Up to 2.5k-bytes of ROM and 64 bytes of RAM are available on-chip. The INS8073 is a programmed version of the INS8072 with a Tiny Basic microinterpreter on-chip. The microinterpreter executes source code directly, thus avoiding the need to translate the source code into machine language. This approach allows users to develop system software without using a development system and gives a greater flexibility for design changes.

The ADC0801 series, the ADC0808 series, and the ADC0816 series are CMOS 8-bit successive approximation A/D converters that include TRI-STATE® latched outputs and control logic for parallel I/O. These A/Ds can be mapped into memory space or they can be controlled as I/O devices. The ADC0801 series includes a differential input and span adjust pin, while the ADC0808 and ADC0816 series

include an 8- or 16-channel multiplexer with latched control logic.

The ADC0831 series, on the other hand, are CMOS 8-bit successive approximation A/D converters with serial I/O. In addition to the single analog input ADC0831 in an 8-pin miniDIP, they offer 8, 4, or 2-channel analog multiplexed inputs. Serial output data can be selected as either MSB or LSB first. The channel assignment of the multiplexers is accomplished with a 4-bit serial input word preceded by a leading "1" start bit.

The ADC0801, ADC0802, ADC0803, ADC0804 parallel I/O A/Ds and the ADC0833 serial I/O A/D are designed to work with a 2.5V fixed reference for a 0V to 5V analog input range. The full 8 bits of resolution can be encoded over any smaller analog voltage range by applying one half of the desired full-scale analog input voltage value to the $V_{REF}/2$ pin.

The ADC0805, ADC0808, ADC0809, ADC0816, ADC0817 parallel I/O A/D converters and the ADC0831, ADC0832, ADC0834, and ADC0838 serial I/O A/D converters are designed to operate ratiometrically with the system transducers. A ratiometric transducer is a conversion device whose output is proportional to some arbitrary full-scale value. The actual value of the transducer's output is not important, but the ratio of this output to the full-scale reference is important. Also, these parts are designed to use a 5V fixed reference.

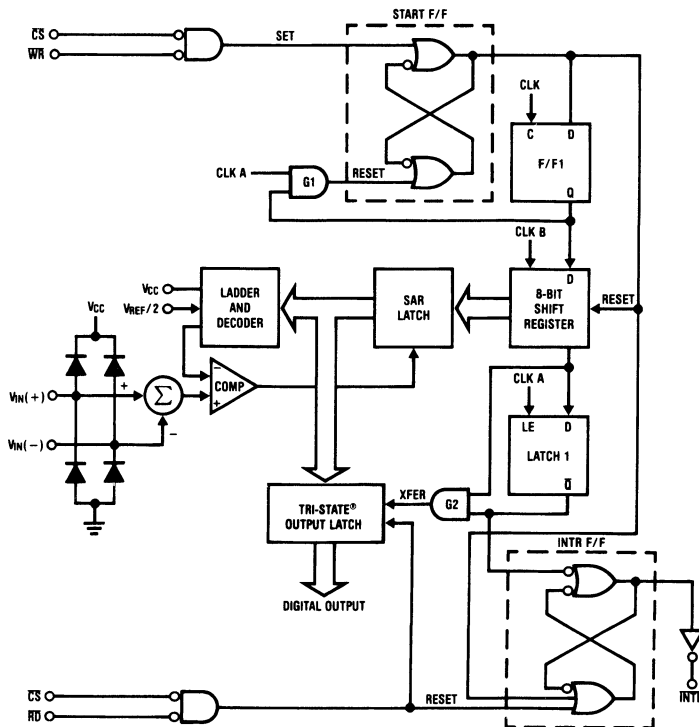


FIGURE 1. ADC0804 Internal Block Diagram

TL/H/5631-1

All of these A/D converters operate from a standard 5V power supply, and are available in accuracies over the temperature range of $\pm 1/2$ LSB or ± 1 LSB including full-scale, zero scale, and non-linearity errors.

ADC0804 IMPLEMENTATION EXAMPLE

Theory of Operation

The converter is started by forcing \overline{CS} and \overline{WR} simultaneously low. This sets the start flip-flop (F/F) (see *Figure 1*) which resets the 8-bit shift register, resets the INTR F/F and sets F/F1, which is at the input end of the 8-bit shift register. When the set signal of the start F/F goes low (either \overline{WR} or \overline{CS} is high), the 8-bit shift register then shifts in a "1" from F/F1, which starts the conversion process. After the "1" is clocked through the 8-bit shift register, it appears as the input to Latch 1. The "1" output from the shift register causes the 8-bit output of the SAR latch to transfer to the TRI-STATE output latches. When Latch 1 is subsequently enabled, the Q output makes a high-to-low transition which sets the INTR F/F. An inverting buffer then supplies the INTR output signal. When data is to be read, the combination of both \overline{CS} and \overline{RD} being low will reset the INTR F/F and will enable the TRI-STATE buffer latch output onto the 8-bit data bus.

1k-byte of external RAM is provided in the INS8073 system, in which the first 256 bytes are used to store the microinterpreter's variables, stacks and buffers. The remainder of the RAM is used to store data and the interface program. The A/D is mapped into the memory space of the INS8073 system at address 3000 HEX. External RAMs are located from 1000 HEX to 13FF HEX. A DM74LS136 address decoder is used to generate the chip select signals for the A/D and the RAM. It also provides a signal to enable a DM74LS368 TRI-STATE HEX buffer which provides the baud rate setting at

location FD00 HEX. The read and write strobe signals of the A/D and the processor are tied together, and the INTR signal of the A/D is tied to the SENSE B input of the INS8073.

The microinterpreter has built-in I/O routines to serially interface with an RS-232 terminal. The INS8073 F1 flag should be inverted and buffered to provide an RS-232 level. Similarly, the INS8073 will accept serial input data, buffered to TTL level without inversion, on its SA input. DS1488/DS1489 quad line driver/receiver chips are used for TTL/RS-232 buffering. Baud rate can be selected by matching the two jumpers, J1 and J2, (see *Figure 2*), with the table below. A "0" signifies that the jumper is missing, and a "1" means that it is installed.

J1	J2	Baud Rate
0	0	4800
0	1	1200
1	0	300
1	1	110

Details of both hardware and software interface are given below and in *Figure 2*. A Tiny Basic subroutine, along with an Assembly Language subroutine, are illustrated. The microprocessor starts the A/D, reads, and stores the results of 16 successive conversions. The 16 data bytes are stored at location 13D0 HEX to 13DF HEX. The Assembly Language subroutine can be called by issuing a "LINK" statement in Tiny Basic. It performs the same function as the Tiny Basic subroutine, except it will execute faster. The Tiny Basic subroutine takes about 60 ms to execute; the Assembly Language subroutine takes only 96 μ s (plus conversion time).

TINY BASIC INTERFACE SUBROUTINE

```

100 REM SUBROUTINE TO START A/D AND STORE DATA INTO MEMORY
110 REM C IS THE COUNTER FOR THE NUMBER OF DATA BYTES STORED
120 REM D POINTS TO THE 1ST DATA ADDRESS
130 C = 16
140 D = # 13D0
150 @ # 3000 = A ;REM START A/D
160 A = STAT AND #20 ;REM LOOP UNTIL SENSE B GOES LOW
170 IF A <> 0 THEN GO TO 160 ;REM (CONVERSION COMPLETED)
180 @ D = @ # 3000 ;REM INPUT CONVERTED DATA
190 D = D + 1 ;REM INCREMENT DT ADDRESS
200 C = C - 1 ;REM CHECK WHETHER 16 CONVERSIONS
210 IF C > 0 THEN GO TO 150 ;REM ARE DONE OR NOT
220 RETURN

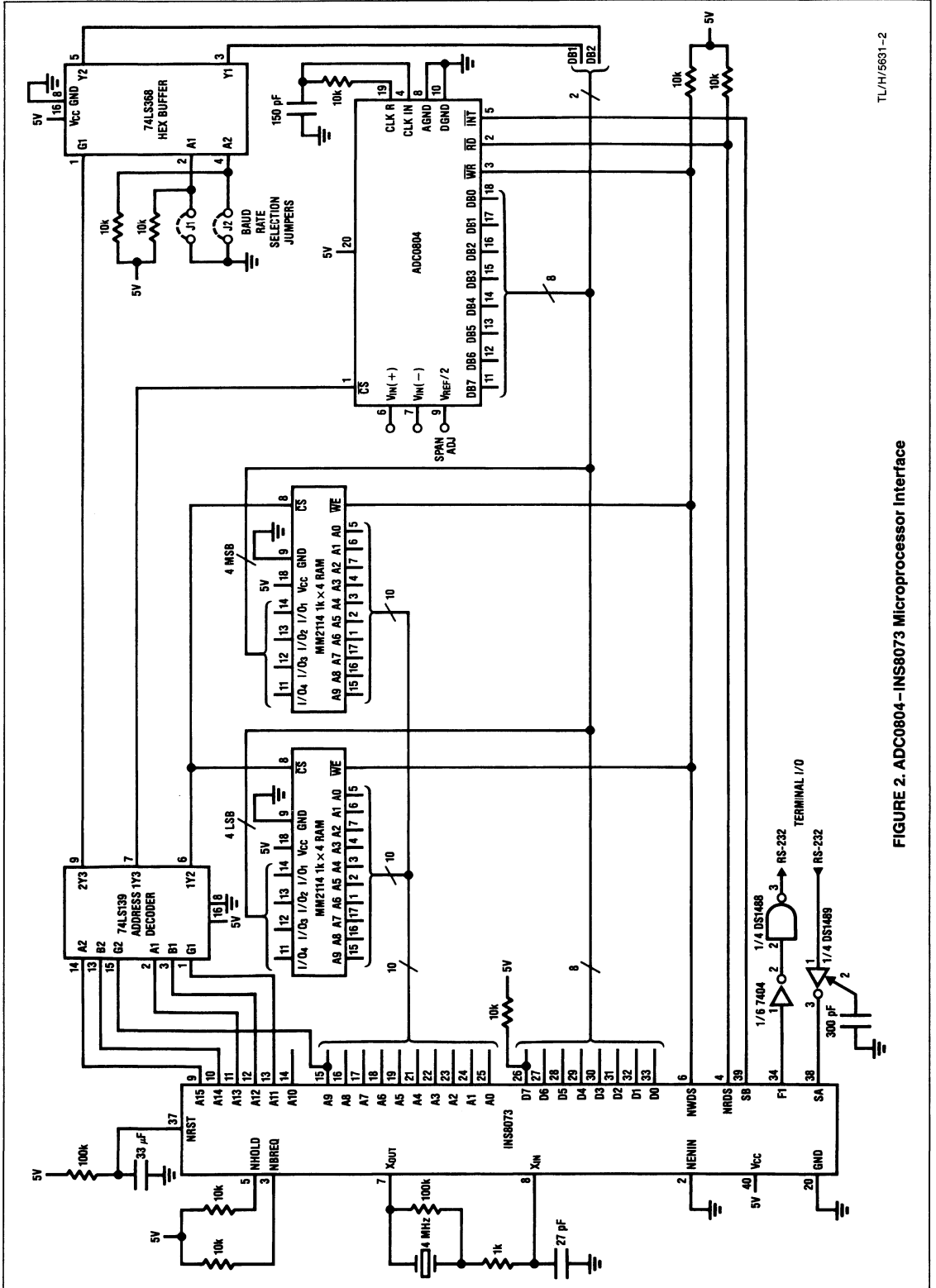
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INS8072 ASSEMBLY CODE INTERFACE SUBROUTINE

```

; THIS SUBROUTINE IS TO BE CALLED BY TINY BASIC THROUGH A "LINK" STATEMENT
BEGIN:  PLI      P2, = 13DOH      ;P2 POINTS TO A 1ST BYTE ADDRESS
        PLI      P3, = 3000H     ;P3 POINTS TO A/D
        LD       A, = 0FH       ;SET CONVERSION COUNTER TO 15
        ST       A, COUNT       ;COUNTER ADDRESS
START:  ST       A, 0, P3        ;START A/D
WAIT:   LD       A, S           ;WAIT FOR SENSE B INPUT TO GO LOW
        AND      A, = 20H       ;(CONVERSION COMPLETED)
        BNZ     WAIT
        NOP
        LD       A, 0, P3       ;INPUT CONVERTED DATA
        ST      @ 1, P2        ;STORE DATA IN MEMORY
        DLD     A, COUNT       ;DECREMENT COUNTER. IF NOT DONE,
        BP      START         ;DO ANOTHER CONVERSION
        POP     P3             ;RESTORE P2 AND P3 FOR TINY BASIC
        POP     P2
        RET                    ;RETURN TO TINY BASIC

```



TL/H/5631-2

FIGURE 2. ADC0804-INS8073 Microprocessor Interface

ADC0833 IMPLEMENTATION EXAMPLE

Theory of Operation

The three flag outputs (F1, F2, F3) and a sense input (SA or SB) are all that is required to interface the ADC0833 and the 70 series family microprocessor (see *Figure 3*). The AND S, = XX and the OR S, = XX instructions set up the status register to produce the proper output signals (D1, CLK, CS). The input is derived by loading the status register into the accumulator and masking all but the necessary bit.

The ADC0833 is selected by setting CS, CLK, and DI low. After setting a counter to account for the 4-bit MUX address and the start bit, the data is shifted out, serially. This is

accomplished by testing the carry bit after each shift and modifying FI accordingly (see Tables I and II and *Figure 4*). Once the leading sentinel bit and all four MUX address bits are clocked in, the A/D input is disabled and DO is enabled. One clock pulse is required to sync the output with the falling clock edge; the falling clock edge is used to clock data out. Each of eight successive input loops load the status register into the accumulator and the masks to determine whether the input was a "1" or "0". After ascertaining which, the result is loaded into the accumulator and the program successively shifts left (for a "0"), or shifts left and adds a "1" (for a "1"). A digitized byte is formed representing the analog input (see *Figures 5 and 6*).

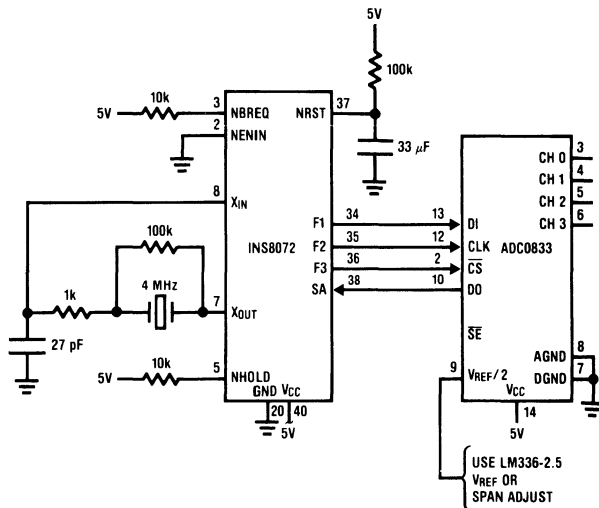


FIGURE 3. A/D Conversion Circuit for Single-Ended MSB First Mode

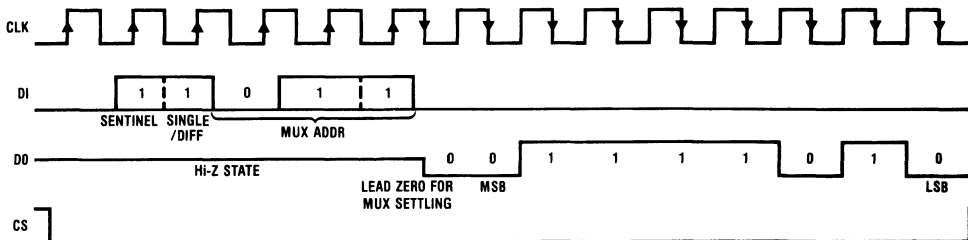


FIGURE 4. Example I/O Transaction (A/D Output = 7A; Channel 2, Single-Ended Selected)

TL/H/5631-3

TABLE I. SINGLE-ENDED MUX MODE

LSB	MSB	S/D	Start	Single-Ended				HEX Code
				0	1	2	3	
1	0	0	1	+				13
1	1	0	1			+		1B
1	0	1	1		+			17
1	1	1	1				+	1F

TABLE II. DIFFERENTIAL MUX MODE

LSB	MSB	S/D	Start	Differential				HEX Code
				0	1	2	3	
1	0	0	1	+	-			11
1	1	0	1			+	-	19
1	0	1	1	-	+			15
1	1	1	1			-	+	1D

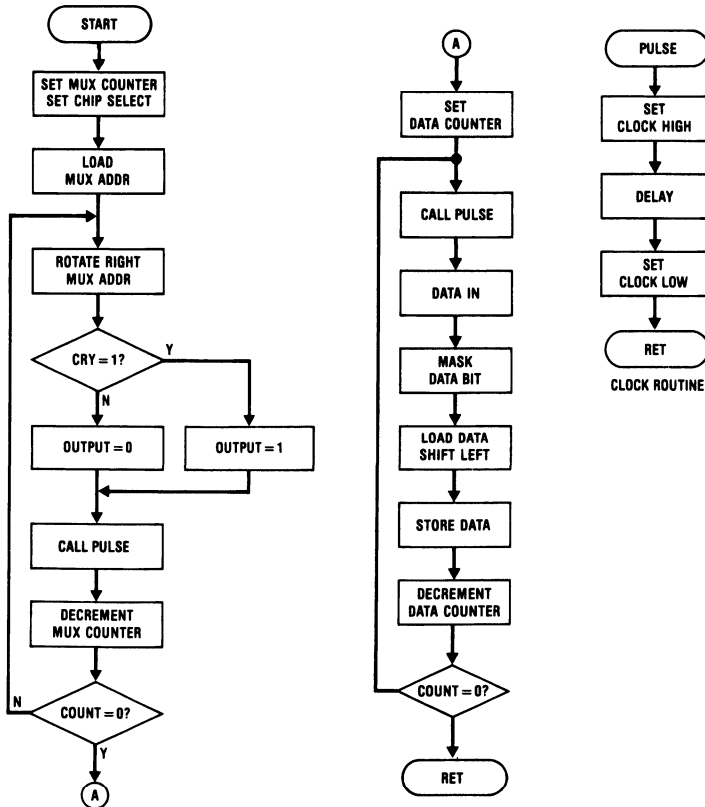


FIGURE 5. A/D Conversion Flow Chart

TL/H/5631-4

```

START:  AND    S,=0F0H      ;SET CS=0, CLK=0
        LD     A,=5
        ST    A, CNTR ADDR ;SET UP MUX ADDR COUNTER
        LD     A,=0
        ST    A, RESLT ADDR ;CLEARS RESULT LOCATION
        LD     A,= MUX ADDR ;LOAD MUX ADDR AND SENTINEL BIT
        JMP    LOOPS
LOOP 1: XCH    A, E        ;RESTORE MUX ADDR REMAINDER
LOOP 5: RRL    A          ;ROTATE BIT 0 INTO CARRY
        XCH    A, E        ;SAVE MUX ADDR REMAINDER
        LD     A, S        ;LOAD STATUS REG
        BP    ZERO        ;IF CARRY NOT SET, OUTPUT="0"
ONE:    OR     S,=02      ;SET F1=1 (D1=1)
        JMP    CONT
ZERO:   AND    S,=0F0H    ;SET F1=0 (D1=0)
CONT:   CALL   PULSE     ;PULSE CLK 0 → 1 → 0
        DLD   A1 CNTR ADDR ;DECR AND LOAD COUNTER
        BNZ   LOOP 1     ;BRANCH IF COUNT=0
        LD    A,=08      ;SET UP DATA BIT COUNTER
LOOP 2: CALL   PULSE     ;PULSE CLOCK 0 → 1 → 0
        LD    A, S        ;LOAD STATUS REG
        AND   A,=01      ;DETERMINE IF DATA="1"
        BZ    IN0        ;IF ACC=0, GO TO IN0
        LD    A, RESLT ADDR ;LOAD CURRENT RESULT
        SL    A          ;SHIFT RESULT LEFT
        ADD   A,=1       ;ENTER LATEST DATA BIT
        JMP   GO
IN0:    LD    A, RESLT ADDR ;LOAD RESULT
        SL    A          ;SHIFT RESULT LEFT, BIT 0=0
GO:     ST    A, RESLT ADDR ;STORE CURRENT RESULT
        DLD   A, CNTR ADDR ;DECR AND LOAD DATA COUNTER
        BNZ   LOOP 2     ;IF COUNTER≠0, CONT
        RET
PULSE:  OR     S,=04      ;SET F2=1 (CLK=1)
        NOP                    ;DELAY
        AND   S,=0FBH    ;SET F2=0 (CLK=0)
        RET

```

FIGURE 6. Single-Ended A/D Conversion Program

Data Acquisition Using INS8048

National Semiconductor
Application Note 281
Daniel Hagerty



Abstract: This application note describes techniques for interfacing National Semiconductor's ADC0833 serial I/O, and ADC0804 parallel I/O A/D converters to the INS8048 family of microprocessors. A hardware and software interface example is provided for each A/D, along with a brief theory of operation.

INTRODUCTION

Since the INS8048 series microprocessors are single-chip, multiple I/O line, high speed devices designed as efficient controllers, the capacity to interface with analog peripherals is obvious. That the conversion be fast, inexpensive and easily expanded to accommodate a number of I/O devices is desirable.

The INS8048 is a self-contained, 8-bit processor in a 40-pin dual-in-line package. It contains its own system timing, control logic and memory. All parts contain RAM (64, 128, 256 bytes) and offer the option of on-board ROM (1k, 2k, 4k depending on part). It provides extensive bit-handling capabilities, 97 instructions, and offers easy expansion for I/O and memory.

The ADC0833 A/D converter is an 8-bit successive-approximation device with serial I/O and conversion time of 25 μ s. This family of converters offers various configurations of multiplexed analog inputs which can be software programmed as single-ended, or as differential inputs, or both. Single-ended inputs are referenced to a common pin which is either referred to analog ground or to a fixed reference voltage. Like the INS8048 family, a single 5V power supply is all that is needed. The inputs will accept a 0V-5V range. No zero adjust is necessary. It is compatible with TTL and MOS at both input and output. The output can be selected as either MSB or LSB first.

The ADC0804 is a CMOS 8-bit successive-approximation A/D converter with parallel I/O. This A/D can be mapped into memory space or can be controlled as an I/O device. No external logic is needed to interface with the INS8048. A new differential analog voltage input allows increasing the common-mode rejection and offsetting the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding smaller voltage spans to the full 8 bits of resolution.

ADC0833 IMPLEMENTATION

Before explaining the system configuration, it is worthwhile for one to understand the operation of the INS8048 processor's I/O ports. Ports 1 and 2 are quasi-bidirectional; that is, they can be used as inputs or outputs while being statically latched. If a "1" is written into any port bit, that bit can function as an input or as a high level output. If a "0" is written into any port bit, that bit can function only as a low level output. Outputs are latched until changed and inputs are unlatched and must be read immediately. When used with the ANL Pp,A (AND accumulator to port) or the ORL Pp,A (OR accumulator to port) instructions, these ports provide an efficient means of handling single line inputs and outputs. Port expansion, if anticipated, is handled via the lower four bits of Port 2. These four bits fulfill three distinct functions:

- (1) A quasi-bidirectional static port
- (2) The four high order address bits for external memory
- (3) An expander port interface

Only four pins of the processor's Port 1 or Port 2 are needed for physical interfacing (see Figure 1). The ANL or ORL instructions set up the port pins to produce the proper outputs (CS, CLK, and the multiplex address) or to allow for data input from the A/D converter.

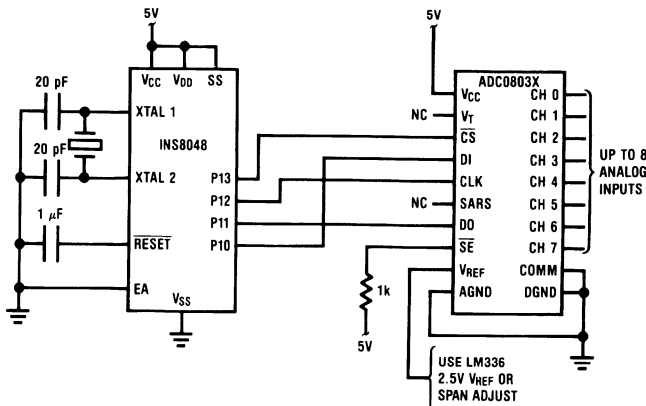


FIGURE 1. A/D Conversion Circuit for Single-Ended MSB First Mode

TL/H/5632-1

The following description of the program can be used with the listing or flow chart to understand the procedure. To begin conversion, the processor must drive CS low, resetting the multiplex address shift register, the successive-approximation register and the 9-bit shift register. After the A/D converter has been selected, the multiplexer address is shifted out serially to the converter. The 4-bit multiplexer address is always preceded by a start bit, a "1". The program loads the multiplexer address, start bit and mode bit into the accumulator as a single byte which is processed and shifted out to the converter. By shifting this byte into the

carry, each bit is tested and the appropriate "1" or "0" is output to the port. After five such operations, the start bit is shifted on the rising edge of the clock pulse through the A/D's 5-bit shift register (see *Figures 2 and 3, Tables 1 and 2*). At this point, the digital data input is disabled, and the digital data output enabled. One more clock pulse is needed to synchronize the output on the falling edge of the clock pulse. On each successive clock pulse, data is shifted serially to the processor. The data bits are then shifted, upon reception, into the accumulator to form the digitized analog input.

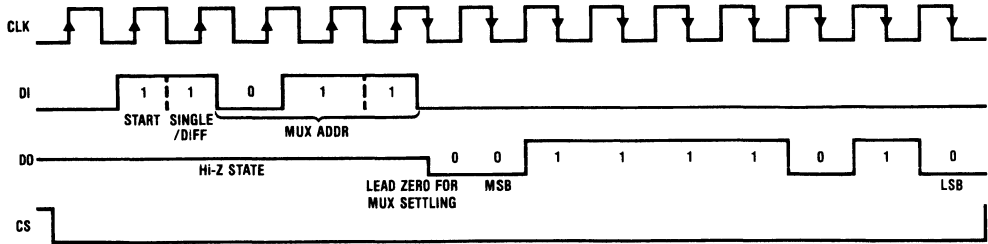


FIGURE 2. Example I/O Transaction (A/D Output = 7A; Channel 2, Single-Ended Selected)

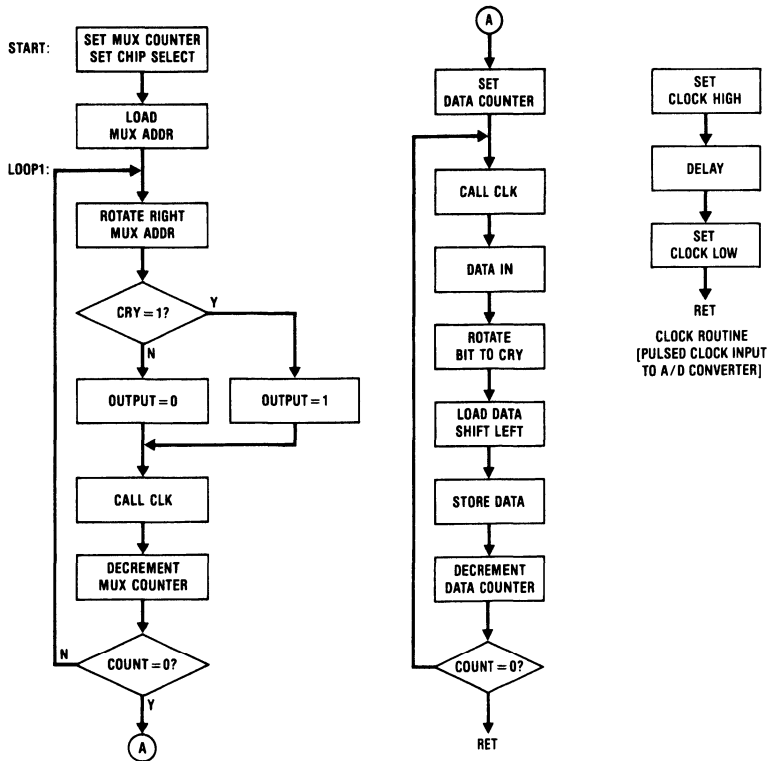


FIGURE 3. A/D Conversion Flow Chart

TL/H/5632-2

TABLE I. Single-Ended Mux Mode

LSB	MSB	S/D	Start	Single-Ended				HEX Code
				0	1	2	3	
1	0	0	1	+				13
1	1	0	1			+		1B
1	0	1	1		+			17
1	1	1	1				+	1F

TABLE II. Differential Mux Mode

LSB	MSB	S/D	Start	Differential				HEX Code
				0	1	2	3	
1	0	0	0	+	-			11
1	1	0	0			+	-	19
1	0	1	0	-	+			15
1	1	1	0			-	+	1D

```

START:      ANL      P1, #0F3H      ;SELECT A/D, SET CS0 to 0
            MOV      R2, #5        ;BIT COUNTER ← 5
            MOV      A, #DATA      ;A ← MUX ADDR
            MOV      R3, #0        ;CLEAR R3
LOOP 1:     RRC      A              ;CY ← ADDR BIT
            JC       ONE           ;IF CY = 1 GO TO ONE
ZERO:      ANL      P1, #0FEH     ;SET DI = 0
            JMP      CONT         ;CONTINUE IF 0
ONE:       ORL      P1, #1        ;SET DI = 1
CONT:      CALL     PULSE         ;PULSE CLK 0 → 1 → 0, CLK IN DATA
            DJNZ    R2, LOOP 1    ;LOOP, TO SHIFT AND OUTPUT MUX
            ;ADDR AND SENTINEL
            MOV      R2, #8        ;BIT COUNTER ← 8, FOR SERIAL IN
LOOP2:     CALL     PULSE         ;PULSE CLK 0 → 1 → 0
            IN       A, P1        ;A ← (D0), BIT SHIFTED TO CARRY
            RRC      A
            RRC      A
            MOV      A, R3        ;A ← RESULT
            RLC      A            ;A(0) ← CY, SHIFT LEFT
            MOV      R3, A        ;R1 ← RESULT
            DJNZ    R2, LOOP 2    ;LOOP THRU FOR ALL 8 BITS
            RETR
PULSE:     ORL      P1, #04        ;CLK ← 1
            NOP
            ANL      P1, #0FBH     ;CLK ← 0
            RET
            END      START

```

FIGURE 4. Single-Ended A/D Conversion Routine

Easy expansion, mentioned earlier, has not been forgotten. With the addition of the one chip (see Figure 5), the number of peripherals can be expanded TEN-FOLD! The INS8243 I/O expander consists of five 4-bit bidirectional ports. One port provides the interface with the processor, the other four provide the I/O expansion. The INS8243 I/O expander serves as a direct extension for the resident I/O port of the INS8048 family of processors. The INS8048 instruction set provides four instructions solely for use with this chip. They are:

MOVD Pp,A—Shift accumulator data to addressed port
 MOVD A,Pp—Shift addressed port data to accumulator
 ANLD Pp,A—ANDing accumulator data to addressed port
 ORLD Pp,A—ORing accumulator data to addressed port

The last two instructions can be used in the same way as the ANL and ORL instructions in the first example. It should be noted that only one pin can be used in Port 7, since the INS8243, unlike the INS8048 series, has true bidirectional ports and thus requires that each port be either input or output. Figure 5 shows how 10 A/D converters could be connected to allow up to 80 analog inputs to be monitored at the expense of only four I/O pins on the INS8048 itself.

ADC0804 IMPLEMENTATION

The ADC0801/2/3/4/5 A/D converters have been designed to directly interface with processors similar to the INS8048 family. The A/D is memory mapped into the external data memory space of the INS8048 system. The RD, WR and INTR signals of the A/D, and the processor are tied directly. In the example circuit, an arbitrarily chosen address, E0, is assigned to the A/D, and CS is decoded by a bus comparator, the DM8131. Since the address and the data of the INS8048 processor are multiplexed on the same bus, an inverted ALE signal from the INS8048 is tied to the strobed input of the bus comparator in order to latch the address output from the processor. If no other devices are attached to the INS8048's bus, this decoding can be left off and the CS input to the ADC0804 is simply grounded.

A sample program is shown in Figure 6. The processor starts the A/D, reads and stores the result of an analog-to-digital conversion through an interrupt service routine. This subroutine starts at address 30H, and the external interrupt vector is located at address 03H. The converted data word is stored at on-chip RAM location, 10H. The following is a line by line description of the parallel A/D conversion subroutine.

BEGIN: This is where the program starts execution after having been reset. R0 and R1 are set up with addresses to point to the A/D converter and the address where data is to be stored.

AGAIN: Interrupts are enabled to allow the A/D to signal that it has completed its conversion; arbitrary data is written to the device to start its conversion process.

LOOP: The processor waits here for an interrupt to occur. The interrupt service routine returns with a zero in the accumulator to allow the program to continue at CONT.

CONT: This is where the analog input received earlier is processed.

INDATA: Upon the occurrence of an interrupt, this routine is entered. It reads data from the A/D converter (with a MOVX A,@R0) and puts it into the RAM location pointed to by R1 (MOV @R1, A). The accumulator is cleared in order to pass location LOOP:, (see Figure 6) and control is returned to the user's program.

Upon inspection, it can be seen that each system has its strengths and limitations. Because of the need to handle serial data with loops for input and output, the ADC0833 is approximately five times slower than the ADC0804. Therefore, for raw speed, the ADC0804, at 100 μ s conversion time plus minimal processor service time, is preferable. Faster processors can be used to decrease the response time from any given analog input. All INS8048 series devices are available with clock rates up to 11 MHz. Though slower, the ADC0833 provides up to eight multiplexed inputs configurable in single-ended or differential modes, and uses only four processor I/O pins. In either case, the implementation is not formidable and, with only 2 or 3 chips per system, not expensive.

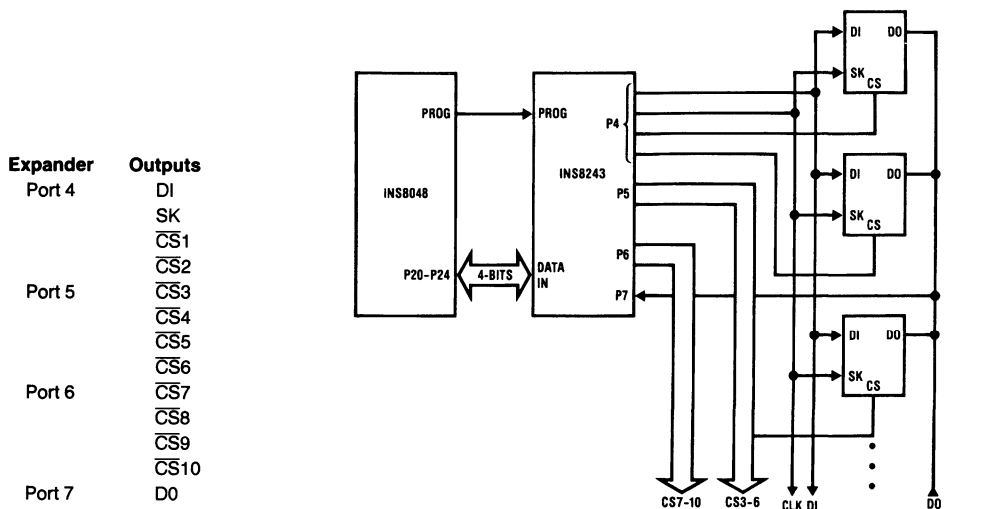


FIGURE 5. I/O Expansion

TL/H/5632-3

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;TEST ROUTINE FOR INTERFACING INS8048 WITH ADC0804
;PROGRAM STARTS AT MEMORY LOCATION 10H
;INTERRUPT SUBROUTINE STARTS AT LOCATION 30H
;DATA WILL BE STORED IN MEMORY LOCATION AT 20H
;
ADDRESS      OBJECT CODE
0000         04 10          JMP      10H          ;PROGRAM STARTS AT 10H
0003         04 30          JMP      30H          ;INTERRUPT VECTOR
0010         B8 E0          BEGIN:   MOV      RO, #0E0H   ;RO POINTS TO A/D
0012         B9 20          MOV      RL, #20H    ;RL POINTS TO DATA ADDRESS
0014         05             AGAIN:   ENI
0015         23 FF          MOV      A, #0FFH    ;SET THE ACC FOR INTR LOOP
0017         90             MOVX    @RO, A        ;START A/D
0018         96 18          LOOP:   JNZ      LOOP    ;LOOP UNTIL INTR FROM A/D
001A         00             NOP
001B         00             CONT:   NOP
                                ;USER'S PROGRAM TO PROCESS
                                ;CONVERTED DATA
                                ;
                                ;INTERRUPT ROUTINE STARTS
                                ;AT 30H
0030         80             INDATA:  MOVX    A, @RO        ;INPUT CONVERTED DATA
0031         A1             MOV      @R1, A      ;STORE IN DATA ADDRESS
0032         27             CLR      A            ;CLEAR ACC TO GET OUT OF
0033         93             RETR     ;THE INTERRUPT LOOP
                                END

```

FIGURE 6. A/D Conversion Routine

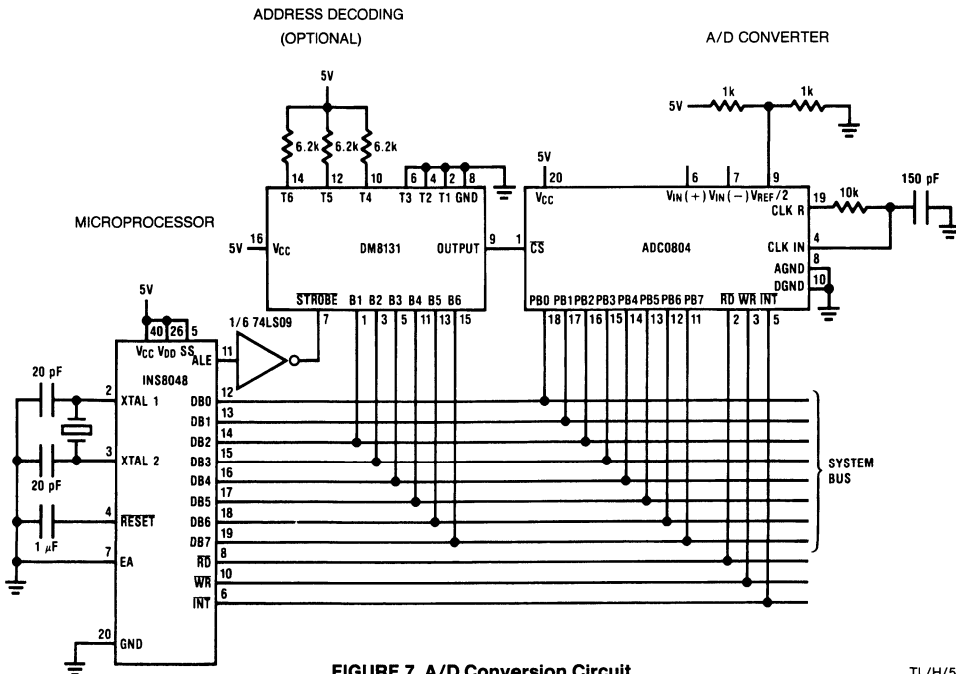


FIGURE 7. A/D Conversion Circuit

TL/H/5632-4

Single-Supply Applications of CMOS MICROADACS

National Semiconductor
Application Note 284
Tim Regan



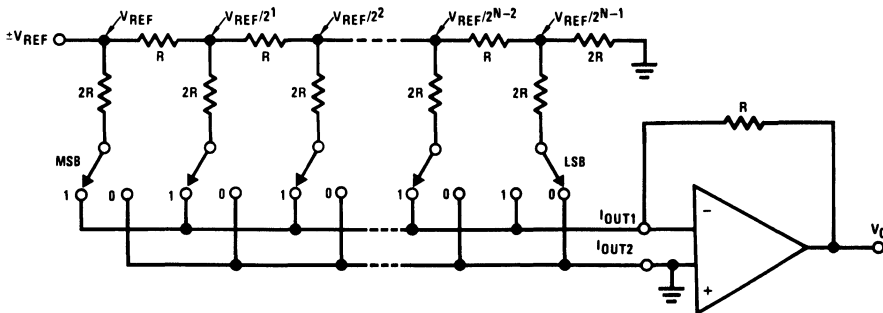
AN-284

CMOS data acquisition and conversion products are becoming the ideal choice for microprocessor controlled analog systems. The use of CMOS allows the addition of more digital logic functionality on to the same die as the analog circuitry to minimize external parts requirements. The inherently low power consumption is also a big factor for battery operation and low heat generation in large scale systems.

National's MICROADAC™ family of 8, 10 and 12-bit D to A converters all feature on-chip data latches to permit direct interface to 8 or 16-bit data busses. These devices were designed to provide the most versatility from an analog standpoint. By utilizing a current switching R-2R ladder network (Figure 1), the applied reference voltage can be either a stable DC voltage or an AC voltage within the wide range of $\pm 10V$. However, output linearity requires that the two current output terminals be biased to 0V. This is accomplished by using an external op amp to serve as a current-to-voltage converter. Negative feedback via the feedback resistor included in the DAC keeps the I_{OUT1} terminal at a virtual ground potential. A drawback to this technique is that the output amplifier inverts and outputs a voltage of the opposite polarity of the applied reference. This then requires the output amplifier to have a negative supply voltage if the reference were positive. To operate with only a single-supply by biasing the ground pin of the DAC and the inputs of the op amp to $\frac{1}{2}$ the supply does not work, as the digital inputs are no longer TTL compatible.

All hope is not lost, however, if single-supply operation is essential. By taking a somewhat backwards view of the DAC ladder network, only a single positive supply is necessary. In Figure 2 the R-2R ladder network is used to switch voltages rather than currents.¹ By applying the reference to the normal current output terminal (I_{OUT1}) and grounding I_{OUT2} the voltage at the reference terminal will be a fraction of the reference voltage and a function of the applied digital input code.

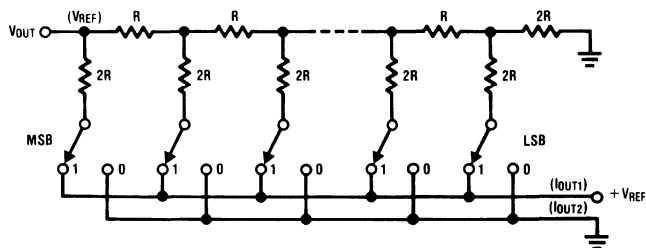
There are two important considerations when using this voltage-switching approach. The applied reference voltage must be positive since there are internal parasitic diodes from the I_{OUT} terminals to ground which would turn on if the reference were to be negative. This, of course, is of no concern with single-supply applications. There is also a dependence of converter linearity and gain error on the voltage difference between the DAC's V_{CC} supply and the applied reference voltage. This is a result of the voltage drive requirement of the CMOS ladder switches. To ensure that all of the switches can turn on sufficiently (so as not to add significant resistance to any leg of the ladder and thereby introduce additional linearity and gain errors) an 8-bit DAC should not have a reference greater than 5V and the V_{CC} supply should be at least 9V more positive than the reference. This would keep linearity and gain error degradation less than 0.1%. A 10-bit DAC is a bit more stringent. For a 0.005% or less error degradation, the reference should be less than $3 V_{DC}$ and V_{CC} should be 10V more positive. The typical effects of bringing V_{REF} and V_{CC} closer together,



N = Number of bits of resolution

TL/H/5633-6

FIGURE 1. The Standard Current-Switching R-2R Ladder Network



TL/H/5633-1

FIGURE 2. Operating the Ladder "Backwards" to Serve as a Voltage-Switching Network

as well as temperature performance, are shown graphically in Figure 3 for the 8-bit DAC0830 series.

Since the output is now a voltage rather than a current, an output op amp is not necessarily required, but the DAC's output impedance is fairly high (equal to its specified reference input resistance of 10k to 20k), so an op amp may be required for buffering purposes. Figure 4 shows a single-supply DAC with an output amplifier providing buffering and gain for a more useful 0V to 10V output from a 2.5V reference. The LM336 reference diode is biased through the internal feedback resistor between the I_{OUT1} pin and the R_{FB} pin. The zero-code output voltage is limited by the lower output saturation voltage of the LM358 op amp. The 2k pull-down load resistor helps to reduce this voltage to 10 mV or 1/4 of an output LSB. Even with a 15V DAC supply, the digital inputs remain T²L compatible.

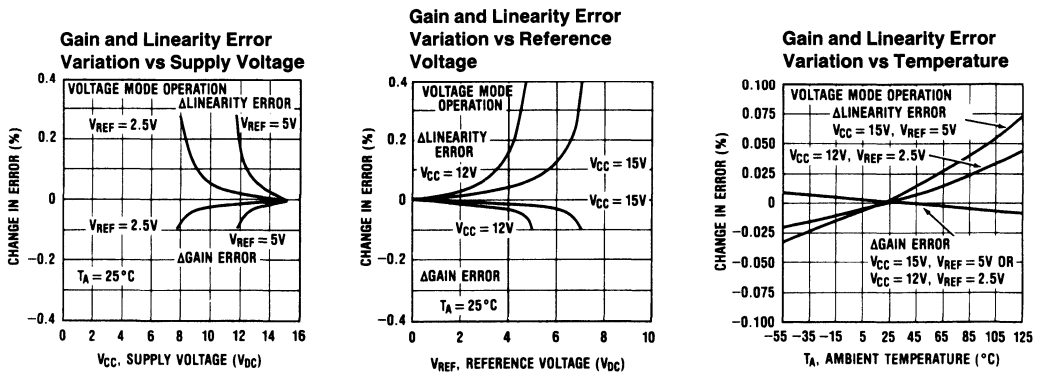
Closer inspection of Figure 2 shows that both I_{OUT1} and I_{OUT2} drive the ladder network in an identical manner. Each leg is connected to either I_{OUT1} or I_{OUT2} as controlled by the logic state of each digital input. If each I_{OUT} terminal is biased to separate reference potentials, the circuit of Figure

5 results. This is a single-supply DAC with an adjustable zero-code output offset voltage and adjustable output span to reserve the full resolution of the DAC for a range of voltages other than 0V to full-scale. An important point to note is that for an all ones code applied, only the voltage at I_{OUT1} is connected to the ladder and sets the output to 255/256 times the voltage of I_{OUT1}. With an all zeros code applied, only the voltage at I_{OUT2} drives the ladder, setting the output to 255/256 times this voltage. This non-interaction of the two inputs at the end-points makes calibration a breeze. The incremental analog output steps are automatically set to (V_{MAX} - V_{MIN})/256.

The buffers at the two reference inputs in Figure 5 isolate the code-dependent resistance to ground at I_{OUT1} and I_{OUT2} from the resistive string used to set V_{MAX} and V_{MIN}. The output responds in accordance to the following expression.

$$(1) V_{OUT} = D/256 (V_{MAX} - V_{MIN}) + 255/256 V_{MIN}$$

Where D is the decimal equivalent of the 8-bit binary control word.



TL/H/5633-2

Note: For these curves, V_{REF} is the voltage applied to the I_{OUT1} terminal and I_{OUT2} is grounded.

FIGURE 3. The Effects of Bringing the V_{CC} Supply and V_{REF} Closer Together and Temperature Performance Using the DAC in the Voltage-Switching Mode

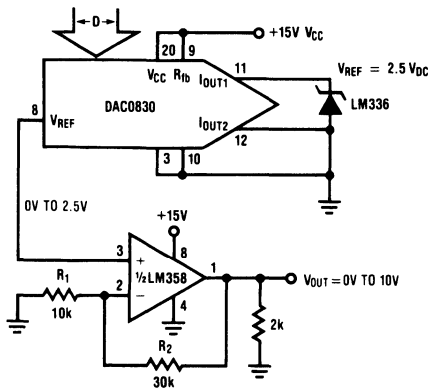


FIGURE 4. Obtaining 0V to 10V Output from a 2.5V Reference

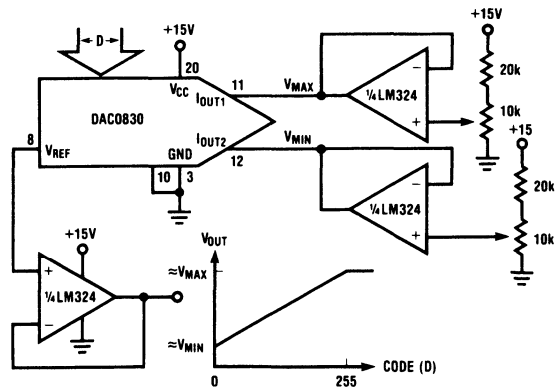


FIGURE 5. A Single-Supply DAC with Level Shift and Span Adjustable Output

TL/H/5633-3

A common requirement of single-supply systems is that the outputs of signal-conditioning amplifiers must be DC biased, typically to $\frac{1}{2}$ of the V_{CC} supply, to provide maximum unclipped AC signal swing. The circuit of Figure 6 shows how this dual-input voltage-switching DAC configuration can allow the digital input code to control the attenuation of an AC signal without significantly affecting the DC biasing level. If the voltage at I_{OUT2} is set to the DC level of the voltage at I_{OUT1} , then the term in equation (1) which is controlled by the digital input code, D , reduces to just the AC signal at I_{OUT1} . The DC level at the output is 255/256 times the DC level at the input.

The circuit of Figure 7 combines the advantages of low power consumption of the CMOS MICRოდACs together with the non-interactive zero and full-scale adjustability of this voltage-switching technique. This circuit is an isolated 4 mA-20 mA current loop controller where the DAC sets the

amount of current that flows through the loop, yet receives its own power from the very same loop.

Digital control and isolation are provided by a single optoisolator and a CMOS counter. The controlling processor must generate a clock and keep track of the number of clock pulses issued to the circuit to know what the loop current is at any time. On power-up the counter is reset to all zeros to give the processor a starting point, as well as to inherently provide a calibration point. When calibrating, potentiometer P1 would be set for the zero-code loop current of 4 mA. The processor would then issue exactly 255 clock pulses to the opto-isolator. Potentiometer P2 can then adjust the full-scale current value to 19.92 mA. If one more clock pulse is issued, the DAC input code returns to all zeros and the previously set value of 4 mA will flow, as this setting was unaffected by the full-scale adjustment.

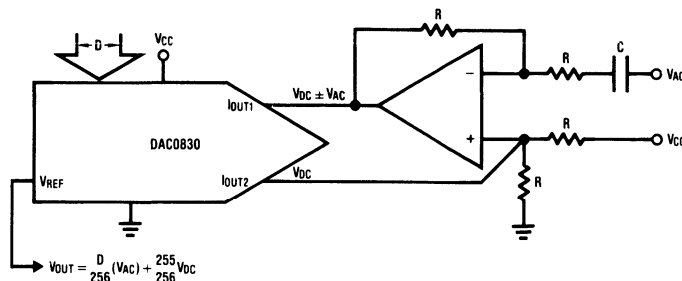


FIGURE 6. Single-Supply DAC where the Digital Input Word Affects the Attenuation of an AC Signal without Significantly Altering its DC Biasing Level

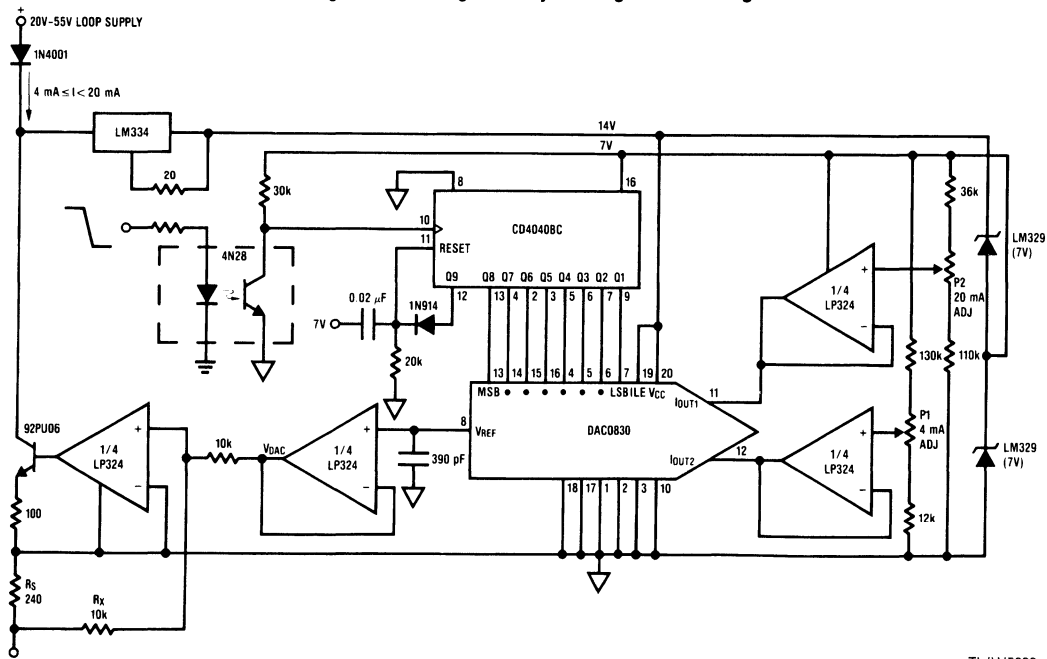


FIGURE 7. Easily Calibrated, Isolated 4 mA-20 mA Current Loop Controller

TL/H/5633-4

The NPN emitter-follower will conduct whatever level of current necessary to keep the voltage across resistor R_S equal to the voltage across resistor R_X . This voltage is equal to the output voltage at the V_{REF} pin of the DAC which can be determined from equation (1). The actual loop current is:

$$(2) I_{LOOP} = V_{DAC}(1/R_S + 1/R_X)$$

The second LM329 reference diode is used to bias the DAC V_{CC} supply higher than the voltages at I_{OUT1} and I_{OUT2} to preserve linearity.

Finally, what if a D to A function is required, but only a single 5V supply is available and minimal supply current is a primary concern (battery powered instrumentation is a good example)? The voltage-switching techniques previously described are not suitable because not enough voltage is available to properly bias the DAC. A CMOS DAC is still attractive for its low supply current requirements and if it can be operated in the standard current switching configuration, a single 5V supply is sufficient. But how about the voltage inversion and the requirement for negative supply potential?

By taking advantage of an age-old technique of clocking a diode-capacitor network connected as a DC to DC voltage inverter, a low current negative supply can be generated. In the circuit of Figure 8, 2 diodes and 2 capacitors are clocked by a CMOS Schmitt trigger oscillator and connected in such a fashion as to generate a $-3.8V$ supply potential. This negative supply is used only to bias a low current LM385-2.5V reference diode to provide the DAC with a stable neg-

ative reference. Now the inversion of the output current-to-voltage converter will generate a positive output ranging from 0V to 2.5V as a function of the digital input code.

The amount of ripple that may appear at the reference input is a function of the dynamic impedance of the LM385, the clock frequency and the size of the switching capacitors. For the component values shown, the clock frequency is approximately 1 kHz and the ripple on the reference is 7 mV peak to peak. This ripple is cleanly filtered by the bypass cap around the feedback resistor of the output amplifier. The output op amp is part of a new low power quad, the LP324, which is ideal for its ability to common-mode to ground on the inputs and swing very close to ground at its output. If an extra CMOS Schmitt inverter is not readily available, the oscillator function can be implemented with another of the amplifiers in the op amp package. The total supply current of this single-supply DAC is on the order of 1.5 mA with no output load.

With this technique even the 12-bit DAC1230 can be used with no linearity degradation which would be apparent in the voltage-switching techniques.

REFERENCE

1. Sevastopoulos, N.; Cecil, J.; and Fredericksen, T., "An Unusual Circuit Configuration Improves CMOS-MDAC Performance", EDN Magazine, March 5, 1979, pg. 77.

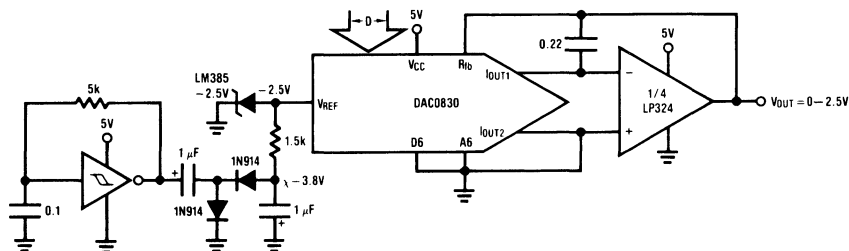


FIGURE 8. Single 5V Supply, 8-Bit CMOS DAC

TL/H/5633-5

An Acoustic Transformer Powered Super-High Isolation Amplifier

National Semiconductor
Application Note 285



AN-285

A number of measurements require an amplifier whose input terminals are galvanically isolated from its output and power terminals. Such devices, often called parametric or isolation amplifiers, are employed in situations that call for measurements in the presence of high common-mode voltages or require complete ground path isolation for safety reasons. Although commercial devices are available to meet these needs, the method of power transfer used to supply power to the floating input circuitry has limited the common-mode voltage capability to about 2500V. In addition, leakage currents can run as high as $2 \mu\text{A}$.

Present devices (Figure 1) employ transformers to transmit power to the floating front end of the amplifier. The output of the floating amplifier is then modulated onto a carrier which is transmitted via a transformer or opto-isolator to the output of the amplifier. Modulation schemes employed include pulse width and pulse amplitude as well as frequency and light intensity coding. The limitation on common-mode voltage breakdown and leakage in this type of device is the breakdown rating of the transformers employed. Even when opto-isolators are used to transmit the modulated signal, the requirement for power to run the floating front end mandates the need for at least one transformer in the amplifier.

Although other methods of transmitting electrical energy with high isolation are available (e.g., microwaves, solar cells) they are expensive, inefficient and impractical. Batteries present an obvious choice but have drawbacks due to maintenance and reliability. What is really needed to achieve extremely high common-mode capability and low leakage is a method for transferring electrical energy which is relatively efficient, easy to implement and offers almost total input-to-input isolation.

ACOUSTIC TRANSFORMERS

A technique which satisfies the aforementioned requirements is available by taking advantage of the piezoelectric characteristics of certain ceramic materials. Although piezoelectric materials have long been recognized as electrical-to-acoustic or acoustic-to-electrical transducers (e.g., buzzers and microphones) their capability for electrical-to-acoustic-to-electrical energy conversion has not been employed. This technique, which capitalizes on the non-conducting nature of ceramic materials, is the key to a super-high isolation electrical transformer. In this device the conventional transformer's transmission medium of magnetic flux and conductive core material is replaced by acoustic waves and a

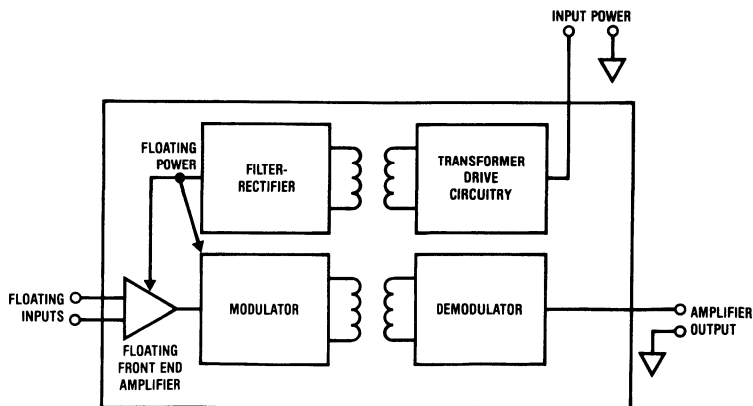


FIGURE 1

TL/H/5634-1

non-conducting piezoceramic core. *Figure 2* shows a photograph of typical acoustic transformers, fabricated by Channel Industries, Santa Barbara, California. Two physical configurations are shown, although many are possible. In each case the transformer is constructed by simply bonding a pair of leads to each end of the piezoceramic material. Insulation resistance exceeds $10^{12}\Omega$ and primary-to-secondary capacitance is typically a few pF. The nature of the piezoceramic material employed and the specific physical configuration determines the resonant frequency of the transformer. *Figure 3* shows a plot of the output of an acoustic transformer driven at resonance. From the data it can be seen that transfer efficiency can exceed 75%, depending upon loading conditions. Output short circuit current for the device tested was 35 mA.

APPLYING THE TRANSFORMER—A 20,000V ISOLATION AMPLIFIER

Figure 4 shows a basic but working design for an isolation amplifier using the acoustic transformer. This design will easily stand off common-mode voltages of 20,000V and versions that operate at 100 kV potentials have been constructed. In this design the acoustic transformer's HI-Q characteristics are used to allow it to self resonate in a manner similar to a quartz crystal. This eliminates the requirement to drive the transformer with a stable oscillator.

The Q1 configuration provides excitation to the transformer

primary, while the diodes and capacitor rectify and filter the secondary's output. *Figure 5* shows the collector waveform at Q1 (Trace A) while Trace B, *Figure 5* shows the secondary output. Despite the distorted drive waveform the transformer's secondary output is a clean sinusoid because of the extremely HI-Q of the device. An LM331 V/F converter is used to convert the amplitude input to a frequency output. The V/F output drives an LED, whose output is coupled to a length of fiber-optic cable. Trace A, *Figure 6* shows the LM331's output, while Trace B indicates the current through the LED. Each time the LM331 output goes low, a short 20 mA current spike is passed through the LED via the $0.01\ \mu\text{F}$ capacitor. Because the duty cycle is low, the average current out of the transformer's secondary is small and power requirements are minimized. At the amplifier output a photodiode is used to detect the light encoded signal and another LM331 serves as an F/V converter to demodulate the frequency encoded signal.

APPLICATIONS

An excellent application for the high isolation amplifier is shown in *Figure 7*. Here, the winding temperature of an electric utility transformer operating at 10,000V is monitored by the LM135 temperature transducer. The LM135 output biases the isolation amplifier input and the temperature information comes out at the amplifier output, safely referenced to ground.

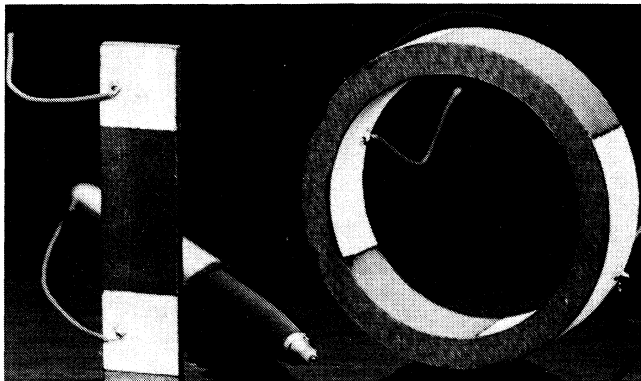


FIGURE 2

TL/H/5634-2

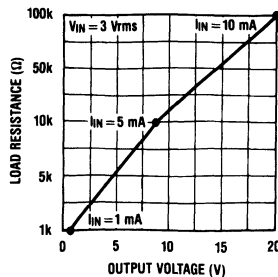
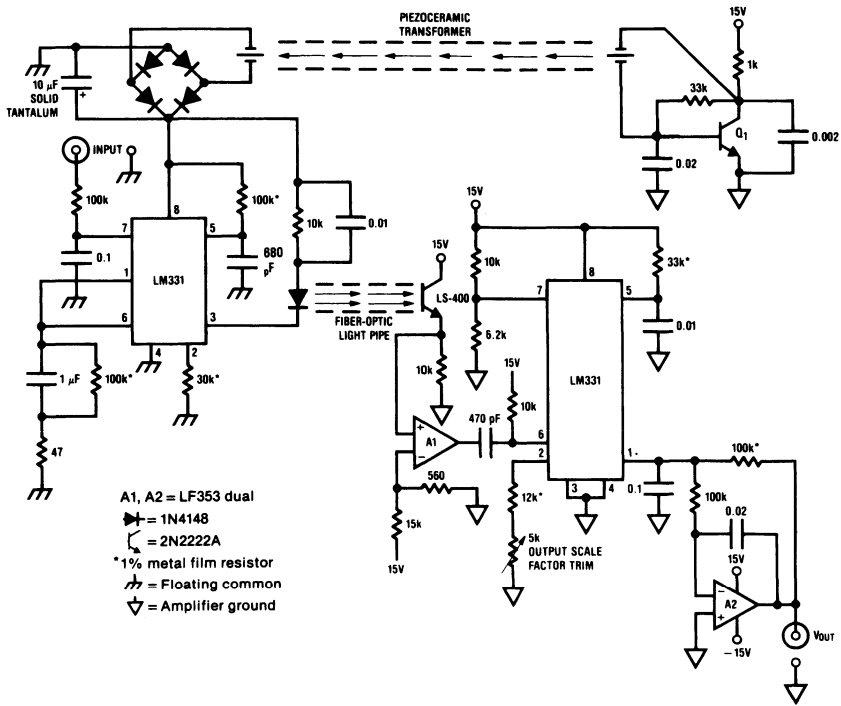
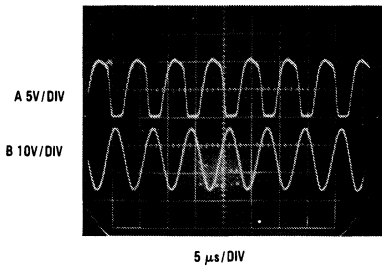


FIGURE 3

TL/H/5634-3



TL/H/5634-4



TL/H/5634-5

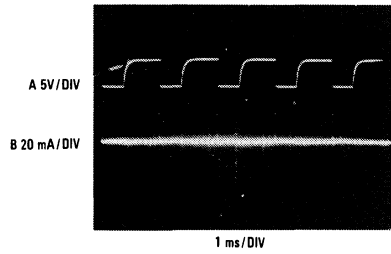


FIGURE 6

TL/H/5634-6

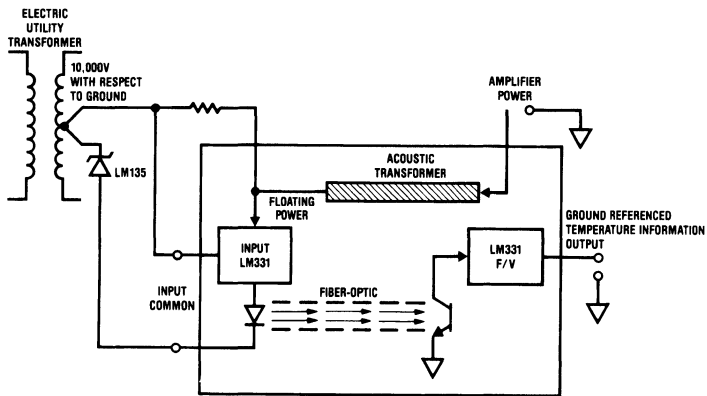


FIGURE 7

TL/H/5634-7

Figure 8 shows another application where the high common-mode voltage capability allows a 5000V regulated power supply to have a fully floating output. Here, a push-pull type DC-DC converter generates the 5 kV output. The piezo-isolation amplifier provides a ground referenced output feedback signal to A1, which controls the transformer drive, completing a feedback loop.

In Figure 9, the piezo-isolation amplifier is used to provide complete and fail-safe isolation for the inputs of a piece of test equipment to be connected into a CMOS IC production line. This capability prevents any possibility of static discharge damage, even when the equipment may have accumulated a substantial charge.

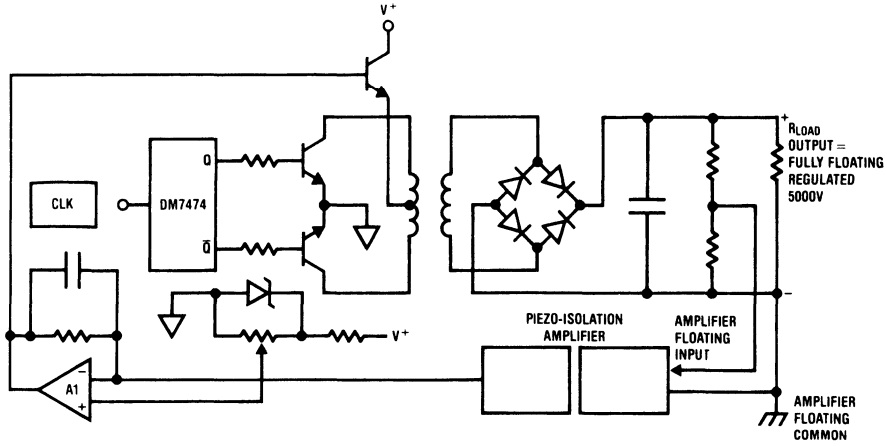


FIGURE 8

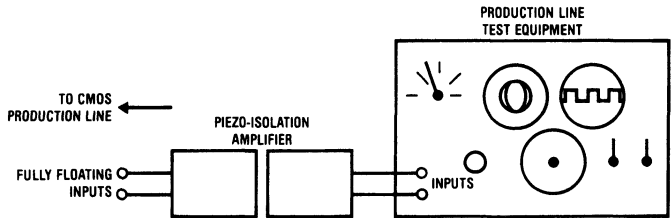


FIGURE 9

TL/H/5634-8

Applications of the LM392 Comparator Op Amp IC

National Semiconductor
Application Note 286



AN-286

The LM339 quad comparator and the LM324 op amp are among the most widely used linear ICs today. The combination of low cost, single or dual supply operation and ease of use has contributed to the wide range of applications for these devices.

The LM392, a dual which contains a 324-type op amp and a 339-type comparator, is also available. This device shares all the operating features and economy of 339 and 324 types with the flexibility of both device types in a single 8-pin mini-DIP. This allows applications that are not readily implemented with other devices but retain simplicity and low cost. *Figure 1* provides an example.

SAMPLE-HOLD CIRCUIT

The circuit of *Figure 1* is an unusual implementation of the sample-and-hold function. Although its input-to-output relationship is similar to standard configurations, its operating principle is different. Key advantages include simplicity, no hold step, essentially zero gain error and operation from a single 5V supply. In this circuit the sample-and-hold command pulse (Trace A, *Figure 2*) is applied to Q3, which turns on, causing current source transistor Q4's collector (Trace B, *Figure 2*) to go to ground potential. Amplifier A1 follows Q4's collector voltage and provides the circuit's output (Trace C, *Figure 2*). When the sample-and-hold command pulse falls, Q4's collector drives a constant current into the 0.01 μF capacitor. When the capacitor ramp voltage equals the circuit's input voltage,

comparator C1 switches, causing Q2 to turn off the current source. At this point the collector voltage of Q4 sits at the circuit's input voltage. Q1 insures that the comparator will not self trigger if the input voltage increases during a "hold" interval. When a DC biased sine wave is applied to the circuit (Trace D, *Figure 2*) the sampled output (Trace E, *Figure 2*) is available at the circuit's output. The ramping action of the Q4 current source during the "sample" states is just visible in the output.

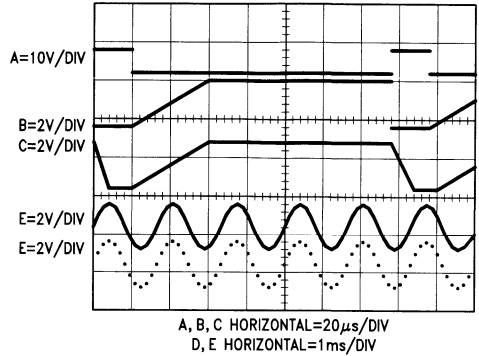


FIGURE 2

TL/H/7493-1

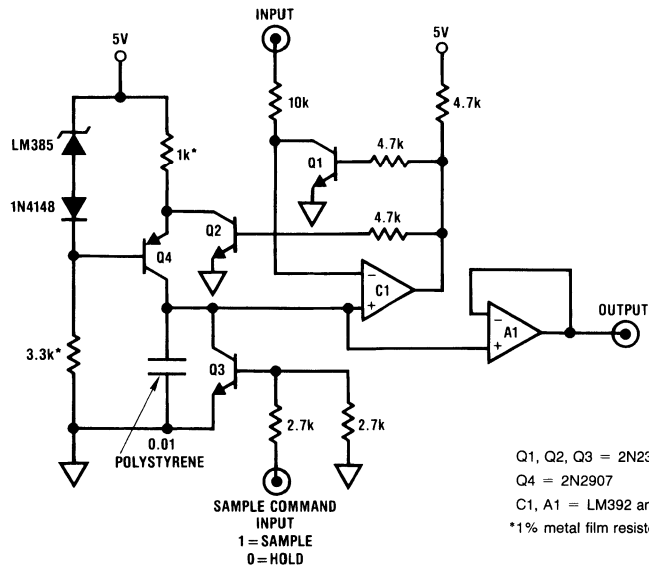


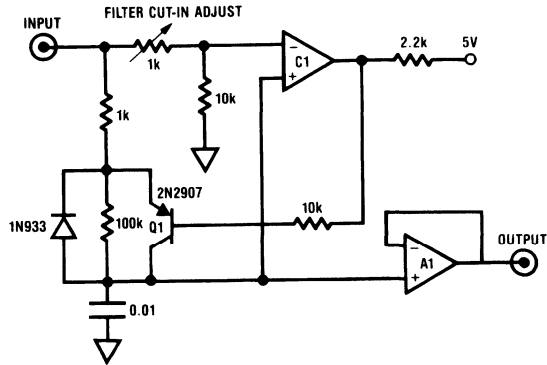
FIGURE 1

TL/H/7493-2

"FED-FORWARD" LOW-PASS FILTER

In *Figure 3* the LM392 implements a useful solution to a common filtering problem. This single supply circuit allows a signal to be rapidly acquired to final value but provides a long filtering constant. This characteristic is useful in multiplexed data acquisition systems and has been employed in electronic infant scales where fast, stable readings of infant weight are desired despite motion on the scale platform. When an input step (Trace A, *Figure 4*) is applied, C1's negative input will immediately rise to a voltage determined by the 1k pot-10 k Ω divider. C1's "+" input is biased through the 100 k Ω -0.01 μ F time constant and phase lags the input. Under these conditions C1's output will go low, turning on Q1. This causes the capacitor (Waveform B, *Figure 2*) to

charge rapidly towards the input value. When the voltage across the capacitor equals the voltage at C1's positive input, C1's output will go high, turning off Q1. Now, the capacitor can only charge through the 100k value and the time constant will be long. Waveform B clearly shows this. The point at which the filter switches from short to long time constant is adjustable with the 1 k Ω potentiometer. Normally, this is adjusted so that switching occurs at 90%–98% of final value, but the photo was taken at a 70% trip point so circuit operation is easily discernible. A1 provides a buffered output. When the input returns to zero the 1N933 diode, a low forward drop type, provides rapid discharge for the capacitor.



A1, C1 = LM392 amplifier-comparator dual

TL/H/7493-3

FIGURE 3

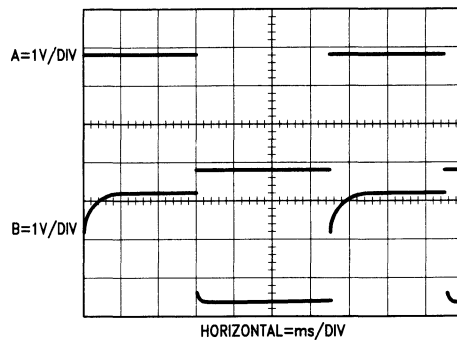


FIGURE 4

TL/H/7493-4

VARIABLE RATIO DIGITAL DIVIDER

In *Figure 5* the circuit allows a digital pulse input to be divided by any number from 1 to 100 with control provided by a single knob. This function is ideal for bench type work where the rapid set-up and flexibility of the division ratio is highly desirable. When the circuit input is low, Q1 and Q3 are off and Q2 is on. This causes the 100 pF capacitor to accumulate a quantity of charge (Q) equal to

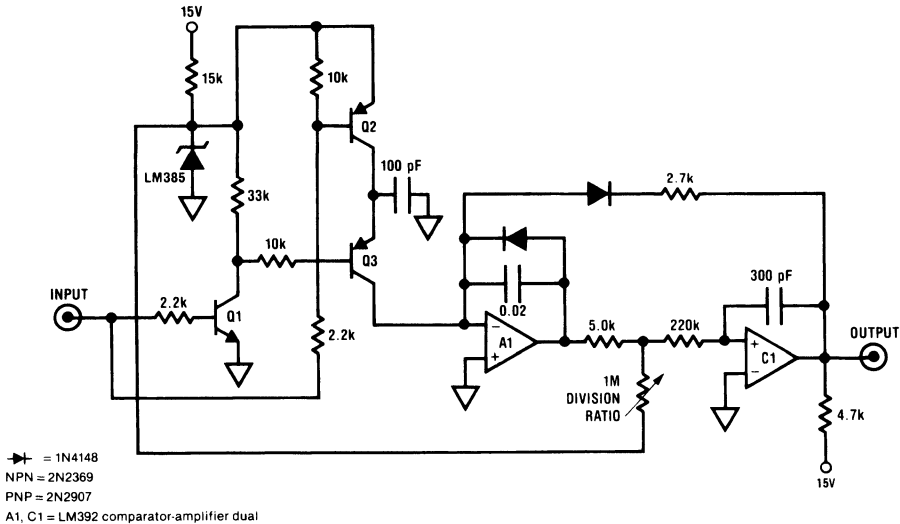
$$Q = CV$$

$$\text{where } C = 100 \text{ pF}$$

$$\text{and } V = \text{the LM385 potential (1.2V) minus the } V_{CE(SAT)} \text{ of Q2.}$$

When the input goes high (Trace A, *Figure 6*) Q2 goes off and Q1 turns on Q3. This causes Q3 to displace the 100 pF capacitor's charge into A1's summing junction. A1's output responds (Waveform B, *Figure 6*) by jumping to the required

value to maintain the summing junction at 0V. This sequence is repeated for every input pulse. During this time A1's output will form the staircase shape shown in Trace B as the 0.02 μF feedback capacitor is pumped up by the charge dispensing action into A1's summing junction. When A1's output is great enough to just bias C1's "+" input below ground, C1's output (Trace C, *Figure 6*) goes low and resets A1 to 0V. Positive feedback to C1's "+" input (Trace D, *Figure 6*) comes through the 300 pF unit, insuring adequate reset time for A1. The 1 M Ω potentiometer, by setting the number of steps in the ramp required to trip C1, controls the circuit input-output division ratio. Traces E-G expand the scale to show circuit detail. When the input (Trace E) goes high, charge is deposited into A1's summing junction (Trace F) and the resultant staircase waveform (Trace G) takes a step.



TL/H/7493-5

FIGURE 5

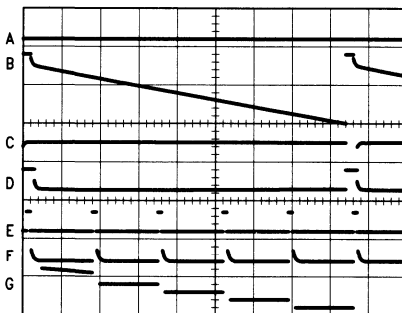


FIGURE 6

TL/H/7493-6

Trace	Vertical	Horizontal
A	10V	500 μs
B	1V	500 μs
C	50V	500 μs
D	50V	500 μs
E	10V	50 μs
F	10 mA	50 μs
G	0.1V	50 μs

governed by the 30 pF-22k time constant (Waveforms A and B, *Figure 8*). The actual integration capacitor in the circuit is the 2 μ F electrolytic. This capacitor is never allowed to charge beyond 10 mV-15 mV because it is constantly being reset by charge dispensed from the switching of the 0.001 μ F capacitor (*Waveform C, Figure 8*). Whenever the amplifier's output goes negative, the 0.001 μ F capacitor dumps a quantity of charge (*Waveform D*) into the 2 μ F capacitor, forcing it to a lower potential. The amplifier's output going negative also causes a short pulse to be transferred through the 30 pF capacitor to the "+" input. When this negative pulse decays out so that the "+" input is higher than the "-" input, the 0.001 μ F capacitor is again able to receive a charge and the entire process repeats. The rate at which this sequence occurs is directly related to the current into C1's summing junction from Q1. Since this current is exponentially related to the circuit's input voltage, the overall I/F transfer function is exponentially related to the

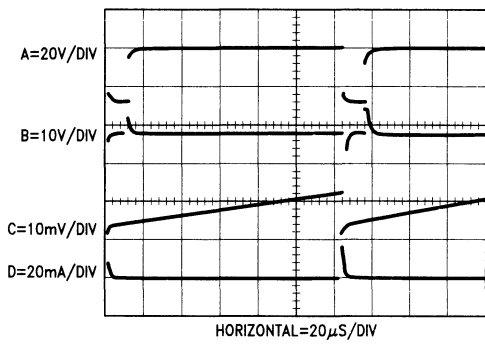
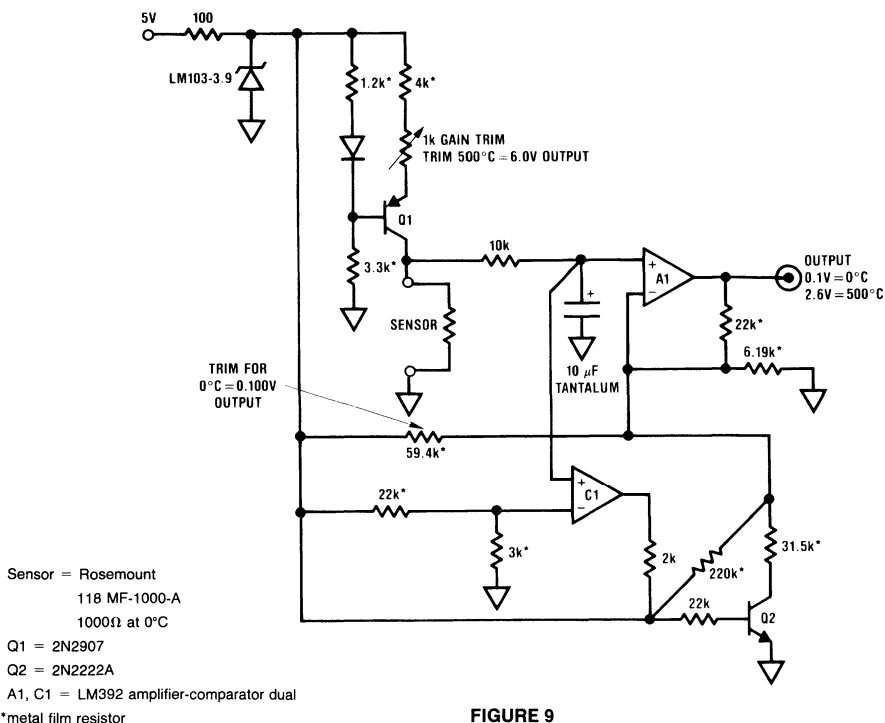


FIGURE 8

TL/H/7493-8



TL/H/7493-9

FIGURE 9

input voltage. This circuit can lock-up under several conditions. Any condition which would allow the 2 μ F electrolytic to charge beyond 10 mV-20 mV (start-up, overdrive at the input, etc.) will cause the output of the amplifier to go to the negative rail and stay there. The 2N2907A transistor prevents this by pulling the "-" input towards -15V. The 10 μ F-33k combination determines when the transistor will come on. When the circuit is running normally, the 2N2907 is biased off and is effectively out of the circuit. To calibrate the circuit, ground the input and adjust the zero potentiometer until oscillations just start. Next, adjust the full-scale potentiometer so that frequency output exactly doubles for each volt of input (e.g., 1V per octave for musical purposes). Repeat these adjustments until both are fixed. C1 provides a pulse output while Q5 AC amplifies the summing junction ramp for a sawtooth output.

LINEARIZED PLATINUM RTD THERMOMETER

In *Figure 9* the LM392 is used to provide gain and linearization for a platinum RTD in a single supply thermometer circuit which measures from 0°C to 500°C with $\pm 1^\circ\text{C}$ accuracy. Q1 functions as a current source which is slaved to the LM103-3.9 reference. The constant current driven platinum sensor yields a voltage drop which is proportionate to temperature. A1 amplifies this signal and provides the circuit output. Normally the slight nonlinear response of the RTD would limit accuracy to about ± 3 degrees. C1 compensates for this error by generating a breakpoint change in A1's gain for sensor outputs above 250°C. When the sensor's output indicates 250°C, C1's "+" input exceeds the potential at the "-" input and C1's output goes high. This turns on Q2 whose collector resistor shunts A1's 6.19k feedback value, causing a gain change which compensates for the sensor's slight loss of gain from 250°C to 500°C. Current through the

220k resistor shifts the offset of A1 so no "hop" occurs at the circuit output when the breakpoint is activated. A precision decade box is used to calibrate this circuit. With the box inserted in place of the sensor, adjust 0°C for 0.10V output for a value of 1000Ω. Next dial in 2846Ω (500°C) and adjust the gain trim for an output of 2.60V. Repeat these adjustments until both zero and full-scale are fixed at these points.

TEMPERATURE CONTROLLER

Figure 10 details the LM392 in a circuit which will temperature-control an oven at 75°C. This is ideal for most types of quartz crystals. 5V single supply operation allows the circuit to be powered directly from TTL-type rails. A1, operating at a gain of 100, determines the voltage difference between the temperature setpoint and the LM335 temperature sensor, which is located inside the oven. The temperature setpoint is established by the LM103-3.9 reference and the 1k-

6.8k divider. A1's output biases C1, which functions as a pulse width modulator and biases Q1 to deliver switched-mode power to the heater. When power is applied, A1's output goes high, causing C1's output to saturate low. Q1 comes on and delivers DC to the heater. When the oven warms to the setpoint, A1's output falls and C1 begins to pulse width modulate the heater in servo control fashion. In practice the LM335 should be in good thermal contact with the heater to prevent servo oscillation.

REFERENCES

1. *Transducer Interface Handbook*, pp. 220-223; Analog Devices, Inc.
2. "A New Ultra-Linear Voltage-to-Frequency Converter", Pease, R. A.; 1973 *NEREM Record* Volume 1, page 167.

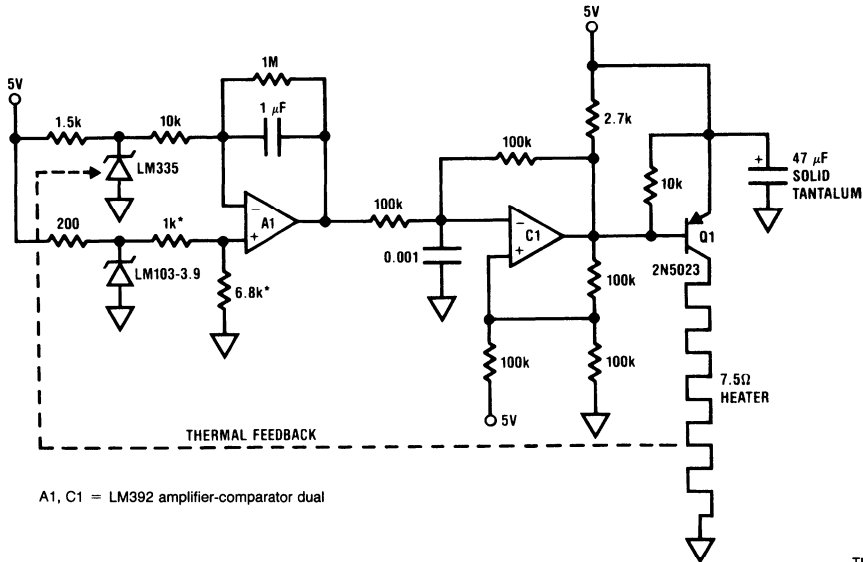


FIGURE 10

TL/H/7493-10

Voice Recording Techniques for Speech Synthesis

National Semiconductor
Application Note 287
Neil Murphy



AN-287



TL/H/7494-1

This note has been written for the users of National Semiconductor's DIGITALKER™ speech synthesis system. DIGITALKER is based on a time domain speech synthesis technique. The ideas presented are intended to be useful to anyone who is selecting and recording a voice for synthesis.

The first section deals with choosing the proper vocabulary, the second with the qualities to look for in a voice, and the third with techniques for recording that voice.

VOCABULARY

It is a common misconception that individual words can be strung together to form natural sounding phrases and sentences. If this were true, words in separate ROM locations could be called up, one by one, to create smoothly connected speech. Unfortunately this is not how it works. You can easily verify this fact by speaking a sentence with every word separated by silence, each with a constant ending intonation. You will undoubtedly recognize these phrases, but they will sound disjointed and unnatural.

Even in situations where it might seem straightforward to use individual words, great care must be given to inflection, for it varies with a word's intent and position in a sentence. The "three" in '... be home by three', won't sound good in '... the total comes to three dollars' because the first "three" has a downward inflection at the end; the second doesn't.

Furthermore, prefixes and suffixes cannot be expected to work with all words. The 'de' in 'demented' probably will not work in the word 'decision', because in the first case, the lips and tongue are shaping for the onset of an 'm', creating an altogether different sound than the shape that anticipates an 's' sound.

Typically, however, this kind of manipulation is often necessary because one wishes to conserve memory by replacing parts of one word with parts of another. When this kind of replacement is planned, special care must be taken in

recording the target words. For example, if a single "ember" is to be used in the words September, November, and December, it must be uttered in a manner which allows this type of transposition. (Voice frequency and tempo must be as uniform as possible for all three.)

Clearly, the best speech results when we are given complete phrases and sentences from which to work. The pitch pattern and pacing of an entire group of words are called from a single address in memory. This type of vocabulary synthesis tends to glue words into their own unique position in the sentence structure. Redundant use of words by concatenation is difficult, and usually represents a quality compromise. As a result, this 'best' approach is also the most expensive in terms of bits-per-word and memory cost.

A second method of vocabulary generation is to synthesize each word separately, but several times with different inflections when needed. Just two versions are, in many cases (such as number strings), quite adequate. The first would be a middle or flat inflection and would be found mid-sentence. The second, inflected downward at the end, would signal the close of a sentence. Clients have used as many as four differently inflected versions of numbers. This method can be expected to produce very understandable speech.

The final and least expensive option is the single word/single inflection vocabulary. Only one version of a word is synthesized, and is called from memory whenever needed. The resultant speech is not as smooth as that of the other methods, but is of adequate quality if care is given to inflection and pacing during recording. The last two methods presuppose redundant use of words, thus memory requirements are reduced. (Note: more on this topic in the section on recording the voice.)

Reasonably compressed sentence structure will also save bits. It's more efficient memory-wise to say "no one's home" than "nobody is at home".

VOICE SELECTION

The human voice is an intriguingly complex and varied instrument. We seek voices which sound smooth, clean, and articulate; avoiding those which are overly breathy, gravelly, or fall outside the parameters of the synthesizer.

The speech which synthesizes best has pitch frequencies, (voiced sounds, such as vowels) which fall in the range of 80 Hz–350 Hz. The power spectrum of voiced speech extends to about 8 kHz, but it is the lowest pitch frequency, or fundamental, not these higher harmonics, which is of concern. A low pitched male voice can dip under 80 Hz. A child or high-pitched female voice can exceed 400 Hz.

Your choice of a speaking voice will also depend on your purpose. Do you want your listener to make a casual stop for gas before the tank runs dry, or to gain altitude immediately to avoid a collision which would take hundreds of lives? It is possible that the appropriate voice may be your own, but most likely, the voice of a trained professional will be better. If you live in or near a city which has talent agencies, they can provide tapes of their artists for your review. The purpose of these tapes is to demonstrate the range and flexibility of these voices. Bear in mind that many professionals cultivate a style which insures them a niche in the business. An exaggerated style may be your key to success, but most likely will become intolerable or, at best, superficial after repeated listenings.

Because even good-sounding voices often have subtle characteristics which make synthesis difficult, National Semiconductor has assembled a group of proven speech talent, professional men and women who are specialists in delivering language in a clear and expressive manner.

If you prefer to locate your own talent, we suggest that a taped sample of the prospective voice be submitted to National Semiconductor in Santa Clara for evaluation. Initially, the speech is digitized (loaded into the computer by converting a continuously varying analog waveform into a discrete train of numerical equivalents), then it is graphically displayed and analyzed. Finally, synthetic waveforms are generated, played, and critically auditioned.

During this process, direct communication between the client and the staff at National's speech lab is extremely important, to avoid problems which may arise should the customer choose an inappropriate voice.

The next step in the pre-synthesis process is to produce a master recording of the entire vocabulary. This tape may be generated in two ways. (A) you may either use National's recording facilities in Santa Clara, or (B) produce the recording yourself in your own locality.

Making use of National's sound studios and engineers assures that the talent will have the kind of coaching and direction we have found to be the most effective. If you prefer to produce the recording yourself, the remainder of this paper will discuss the techniques and guidelines that we use in Santa Clara.

RECORDING THE VOICE

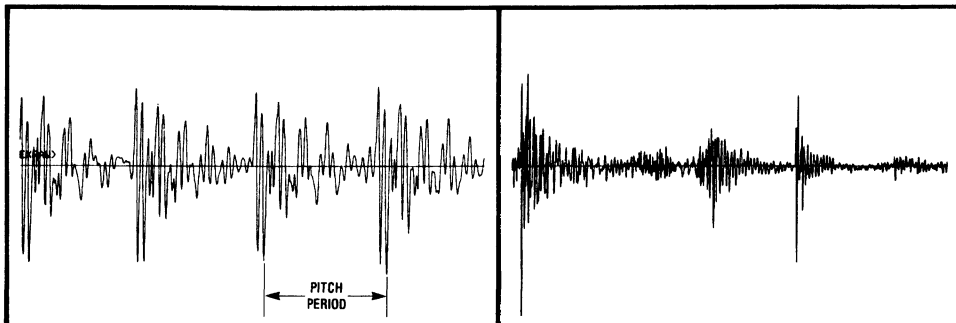
If at all possible, have the work done at a professional recording studio. These facilities have the best microphones, recorders, nonreverberant booths, and of course, engineers who are experienced voice recordists.

The following are a few technical specifications. The tape should have a section of leader at both ends, and ideally between major sections (such as between different speakers). A reference tone (0 dB @ 1 kHz) should precede the spoken portion so that the playback level of another machine can be matched accurately to the record level of the mastering recorder. Tape speed can be either 7.5 inches/second (19 cm/second) or 15 inches/second (38 cm/second) and the format either full or half track on professional quality 1/4 inch tape (such as Scotch 226 or BASF SPR 50 LH). All tapes should be carefully indexed and should include an accurate script of all words and phrases as they are spoken. Non-English vocabularies should be accompanied by an English translation.

Be sure that the recording engineer uses close-microphone techniques [microphone placed 4–10 inches (10 cm–25 cm) from the speaker's mouth]. This increases the ratio of direct to reflected sound, and results in more 'presence' and clarity.

When a speaker looks from one page of a script to an adjacent one, or moves from the bottom of one page to the top of another it is possible that the angle of incidence to the microphone will change enough to affect frequency response and signal level. Watch carefully for these changes. Move the script, not the position of the speaker's head. Utilizing only a small portion of each page for the script may help.

Examples of Good Quality and Bad Quality Voice Characteristics



A

B

TL/H/7494-2

Samples of Voice Waveforms

A) Smooth, even pitch periods from a voice which synthesized well.

B) Irregular pitch periods from a poorly recorded, improperly chosen voice.

A section of tape, recorded with a high amplitude signal, often imprints a faint image of that signal on an adjoining layer. This is detected by the ear as a pre-echo and is known as print-through. It can be minimized by storing and shipping tapes in a "tails-out" condition (do not rewind after your last listening). This will not only reduce the effects of print-through, but will also leave the tape wound with even tension.

Coaching and directing during a session can be either rewarding or frustrating, depending on your preparation and expectations. Take breaks occasionally to listen to the tape. This will give both you and the talent a brief rest, and an opportunity to chart your progress.

Whether you're recording complete sentences or single words from a list, be sure the tempo is brisk and pitch inflection not exaggerated. The ability of the DIGITALKER to track pitch, or frequency-slew, is limited at low bit rates, so rapid pitch-inflection changes are expensive to synthesize.

All words or phrases should be repeated 3 times in succession, with a pause between each one. Then the entire script should be repeated in the reverse order, once again repeating each phrase or word three times. The best take will be chosen from the six versions. Obviously, if you haven't achieved a good take in six tries, continue until you do. Note the bad takes on the script, or edit them out. It's a good idea to record individual words in a pseudo context. For example, if you are recording all the numbers with an ending "downward" inflection, the script might read like this: "the last word is (slight pause) . . . one." (repeat $\times 3$); "the last word is (slight pause) . . . two." (repeat $\times 3$); "the last word is (slight pause) . . . three." (repeat $\times 3$); and so on. Typically and improperly, numbers are recorded in sequence and once again inflections and speed change as one nears the end of the sequence. Reversing the order, or randomly speaking numbers generally provides a uniform set.

If you are recording a vocabulary of single words which are to be concatenated into phrases, be sure that pacing, pitch, and inflection all remain as constant and even as possible. Ending inflections must be flat if the words are to join smoothly. If the context in which the words will be used is known, record the appropriate phrases several times also.

Individual words are often spoken too slowly, especially at the end of a recording session when the talent becomes fatigued. (It's always a good idea to listen again to the beginning of the tape to make sure pitch and pacing have been uniform throughout.) Once again, recording the vocabularies in the forward and reverse directions usually minimizes this problem.

Be sure all unvoiced consonants are clearly enunciated. In the spoken phrase "not now" the "t" is rarely enunciated. For synthesis purposes it should be.

In conversation, words tend to "blend" into their neighbors. "Please say yes" is usually spoken as one continuously varying sound. It's difficult to lift a word from its context and use it elsewhere. If words from recorded sentences are to be concatenated, be sure each one is pronounced completely, distinctly, and separately.

It is a natural assumption that the MM54104 can synthesize sound effects. This is not always true. The MM54104 speech processor chip and its encoding technology were designed to compress, digitize and store high quality

human speech. It is possible, however, to synthesize some types of sound effects. These effects are difficult to categorize, and most are highly memory intensive. Laughter, for example, uses massive amounts of memory because it's often so breathy. If laughter is required, make it as voiced as possible. The best way to evaluate the MM54104's ability to synthesize your sounds is to make a recorded tape of all desired effects and let National Semiconductor's engineers review it and make comments.

The recording stage is probably the least expensive aspect in the synthesis of your vocabulary. By providing us with a word-rich and well produced tape, our word builders will have the best chance of giving you both speech quality and memory economy.

Critique the tape a day or so after the session. Flaws which weren't initially obvious may become apparent. Also, note on the script the client's preferred version of each word or phrase. Keep a reel-to-reel or cassette dub of the master recording for future reference in discussions with National should another choice be necessary.

The next section is for those who can't avail themselves of a professional sound recording service. If this does not apply to you, please skip to the summary at the end of the paper.

CONSTRUCTION OF A RECORDING FACILITY

To begin with, one should strive for a nonreverberant, acoustically dead environment. Ideally, this means acoustically decoupled walls, ceilings, and floors. In order to avoid standing waves, no two walls should be parallel. The floor should be well carpeted and the ceiling lined with acoustic tiles. Fiberglass insulation behind tautly stretched heavy cloth makes an excellent interior wall surface. Such a room should be relatively free of resonances. Foam rubber sheets, either suspended or mounted on floor-standing wooden frames, make good portable sound baffles.

Isolation from outside ambience is just as important. Concrete walls are common and attenuate external sounds fairly well. Double wall construction is preferred, with air gaps and/or insulating material between. Fiberglass under sheet rock can be added to existing walls, or if new construction is to be undertaken, double plywood walls with an inch or so of sand between them are an excellent sound insulator. Any interior windows should be double-paned and designed to have nonparallel surfaces. Take care to seal or baffle any air paths to the outside, such as air conditioning or conduit for power lines.

Most people speak best when standing, so some kind of podium or music stand should be used to hold the text. If the podium has a hard flat upper surface, a piece of carpet will diminish unwanted sound reflections.

The microphone types most often used in speech recording are dynamic and condenser. Dynamic microphones operate on the moving coil principle, and are less susceptible to damage from moisture and rough handling. Condenser microphones generate an audio voltage from a pressure-sensitive capacitive element. Their sensitivity and transient response are extremely good, but since they usually contain a preamplifier, they require a power source. Many condenser microphones have an internal battery, or external in-line battery supply. A good quality microphone of either general type will do an excellent job.

Whatever type you choose, be aware that a good quality microphone will cost at least several hundred dollars.

Microphones range from highly directional to nondirectional (omnidirectional). Nondirectional microphones have some advantages in speech recording. Their off-axis frequency response is usually very uniform and they are fairly insensitive to proximity effect (the enhancement of bass response when speaking close to the microphone). They also have a certain immunity to breath pops. (A good windscreen, however, should be used with all microphones.) Their only disadvantage is that they pick up sound from all directions, not just from the person speaking. If you are recording in a properly prepared room, this last qualification becomes more or less insignificant, and the omni is preferred.

Directional microphones (unidirectional and cardioid) are appropriate in slightly noisier environments, if the microphone-speaker distance is increased slightly to offset any proximity effect and possible breath pops.

It is always a good idea to use a microphone suspension system or shockmount. This device acts as a filter, and isolates the microphone from low frequency floor and stand vibrations by absorbing them before they reach the microphone casing. You will also probably want to use an electronic high pass filter (set at 80 Hz or so) to further isolate the microphone from this type of noise.

A standard and safe microphone position is to angle the microphone approximately 45 degrees from the horizontal, pointed downward, 4 to 10 inches from the speaker's mouth. If breath noise and "pops" are a problem, pull the microphone back and up a little bit, or angle it in more from the side. The latter often allows closer microphone positioning and better view of the text. Closer is generally better! (Note: These 'off-axis' techniques will work better with an omnidirectional microphone.)

Tape recorders are as varied as microphones. Here too, quality is of prime importance. Good speech requires a 1/4 inch tape reel-to-reel machine, recording at no less than 7.5 inches/second (19 cm/second), and a half or full track recording format. Professional tape machines and "top of the line" consumer decks nearly always meet these minimal specifications. Follow the manufacturer's instructions for

demagnetizing and cleaning the heads, and make sure that "tape output" sounds identical to "source (microphone) input" while recording.

SUMMARY

Please remember the following important factors:

- If at all possible, use a professional recording studio.
- Select a voice which is smooth, clear, non-breathy and that produces pitch frequencies between 80 Hz and 350 Hz.
- Send a sample of the voice to National for our engineers to evaluate.
- Record each word, phrase, or sentence a total of six times in the manner described in the section on voice recording. If you are recording a single-word type of vocabulary, pay particular attention to intonations, inflections, and pacing. Keep in mind exactly how the words will be used to create phrases. If the client has a first or second choice, be very sure this preference is indicated. This is especially important in non-English languages. All phrases to be constructed from these single words should also be recorded.
- Upon completion of the tape, evaluate it thoroughly. Make sure the takes meet your best expectations for the total vocabulary.
- Supply an index or script of the entire recording and intended vocabulary. Indicate any words that are considered optional or of less importance. Non-English languages should be accompanied by an English translation.

The engineers of National Semiconductor's speech laboratory believe that adhering to these simple procedures will provide the highest quality DIGITALKER speech with the least amount of displeasure. Additional questions or problems will be readily discussed as they occur.

Note on bibliography: recommend reading applicable sections of "The Audio Cyclopedia" by Howard M. Tremaine. Published by Howard W. Sams and Co., Inc., 4300 West 62nd St., Indianapolis, Indiana 46268, U.S.A.

System-Oriented DC-DC Conversion Techniques

National Semiconductor
Application Note 288



AN-288

In many electronic systems, the need arises to generate small amounts of power at voltages other than the main supply voltage. This is especially the case in digital systems where a relatively small amount of analog circuitry must be powered. A number of manufacturers have addressed this requirement by offering modular DC-DC converters which are PC mountable, offer good efficiency and are available in a variety of input and output voltage ranges. These units are widely applied and, in general, are well engineered for most applications. The sole problem with these devices is noise, in the form of high frequency switching spikes which appear on the output lines. To understand why these spikes occur, it is necessary to examine the operation of a converter.

A typical DC-DC converter circuit is shown in *Figure 1*. The transistors and associated components combine with the transformer primary to form a self-driven oscillator which provides drive to the transformer. The transformer secondary is rectified, filtered and regulated to obtain the outputs required. Typically, the transistors switch in saturated mode at 20 kHz, providing high efficiency square wave drive

to the transformer. The output filter capacitors are relatively small compared to sine wave driven transformers and overall losses are quite low. The high speed, saturated switching of the transistors does, however, generate high frequency noise components. These manifest themselves as short duration current spikes drawn from the converter's input supply and as high speed spikes which appear on the output lines. In addition, the transformer can radiate noise in RF fashion. Manufacturers have dealt with these problems through careful converter design, including attention to input filter design, transformer construction and package shielding. *Figure 2* shows typical output noise of a good quality commercial DC-DC converter. The spikes are approximately 10 mV–20 mV in amplitude and occur at each transition of the switching transistors. In many applications this noise level is acceptable, but in data acquisition and other systems which work at 12-bit and higher resolutions, problems begin to crop up. In these situations, special system-oriented DC-DC converter techniques must be employed to insure against the problems outlined above.

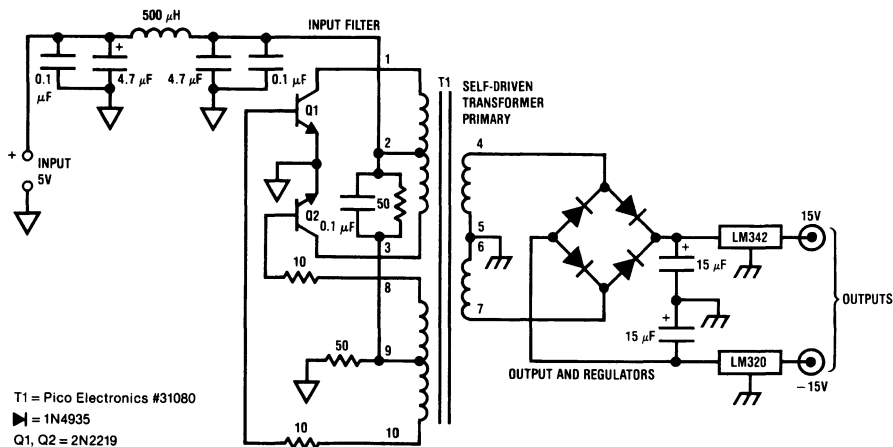
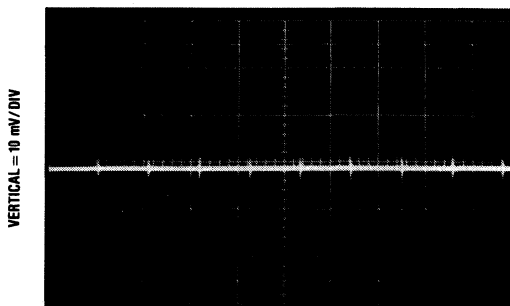


FIGURE 1

TL/H/7495-1



HORIZONTAL = 20 µs / DIV

TL/H/7495-2

FIGURE 2

BLANK PULSE CONVERTER

Figure 3 shows a converter which will supply 100 mA at $\pm 15\text{V}$ from a 5V input. This design attacks the noise problem in two ways. The LM3524 switching regulator chip provides non-overlapping drive to the transistors, eliminating simultaneous conduction which helps keep input current spiking down. The LM3524 operates open loop. Its feedback connection (pin 9) is tied high, forcing the chip's outputs to full duty cycle. Internal logic in the LM3524 prevents the transistors from conducting at the same time. The components at pins 6 and 7 set the switching frequency. The LM3524's timing ramp biases the LM311 comparator to generate a blank pulse which "brackets" the output noise pulse. Figure 4 shows the switching transistor waveforms

(trace A and B) and the blank pulse (trace C) which is issued at each switching transition. The converter's output noise is shown in trace D. The blank pulse is used to alert the system that a noise spike is imminent. In this fashion, a critical A/D conversion or sample-and-hold operation can be delayed until the converter's noise spike has settled. This technique is quite effective, because it does not allow the system to "see" noise spikes during critical periods. This not only insures good system performance, but also means that a relatively simplistic converter design can be employed. The expense associated with low output noise (e.g., shielding, special filtering, etc.) can be eliminated in many cases. Figure 5 details a converter design which uses a different approach to solving the same problem.

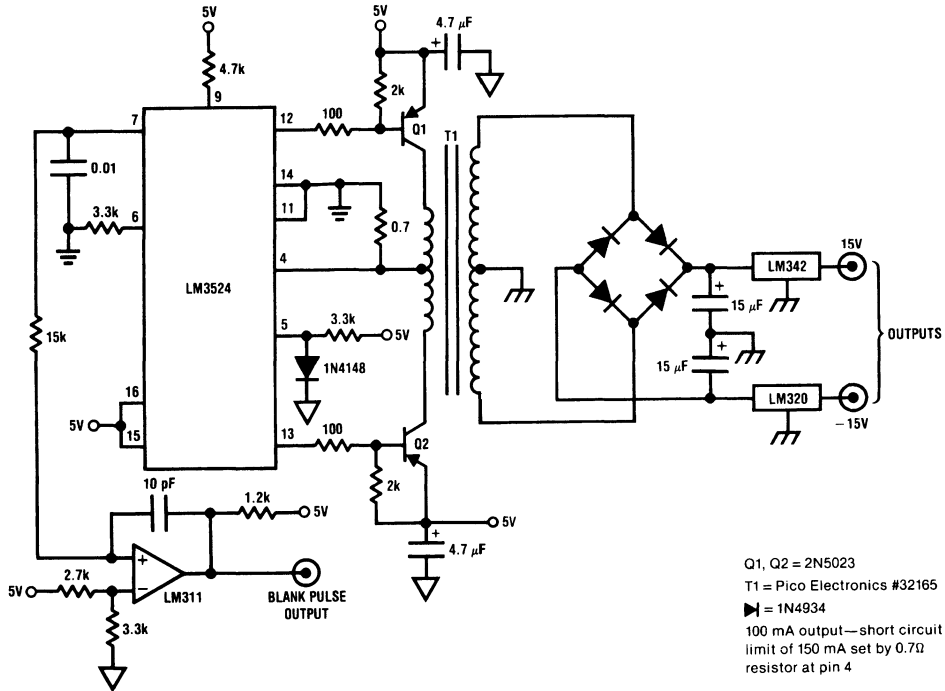
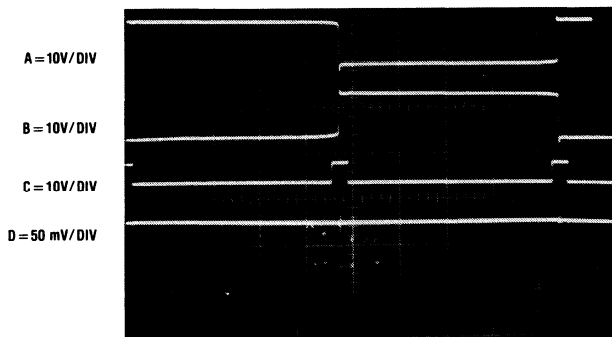


FIGURE 3

TL/H/7495-3



HORIZONTAL = 5 μs /DIV

TL/H/7495-4

FIGURE 4

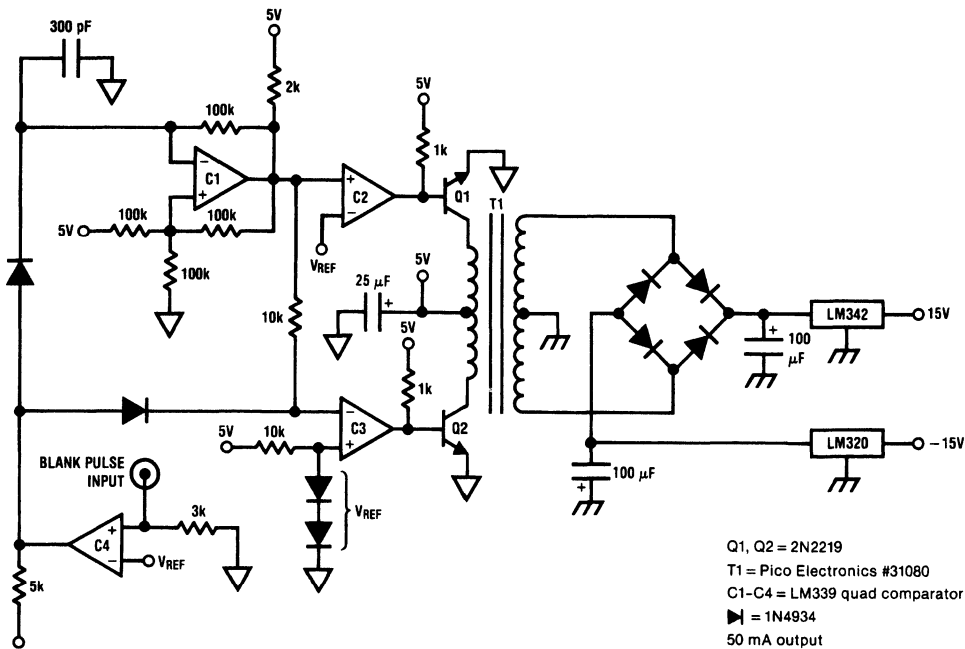
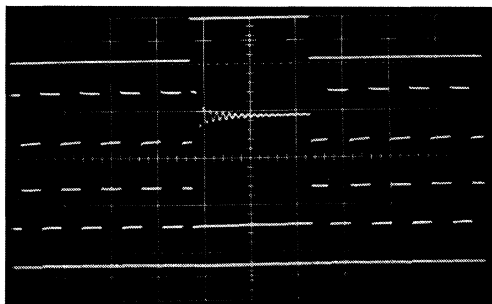


FIGURE 5

TL/H/7495-5

A = 5V / DIV
 B = 5V / DIV
 C = 500 mA / DIV
 D = 20 mV / DIV

HORIZONTAL = 200 μ S / DIV

TL/H/7495-6

FIGURE 6

EXTERNALLY STROBED CONVERTER

In Figure 5 the system controls the converter, instead of the converter issuing blank commands. This arrangement uses an LM339 quad comparator to provide the necessary drive to the converter. C1 functions as a clock which provides drive to C2 and C3. These comparators drive the transistors (trace B, Figure 6 is Q1's collector voltage waveform, while trace C details its current) to provide power to the transformer. When a critical system operation must occur, an external blank pulse (trace A) is applied to C4. C4's output goes high, shutting off all transformer drive. Under these conditions, the transformer current ceases (note voltage ringing on turn-off in trace B) and output noise (trace D)

virtually disappears because the output regulators are powered only by the 100 μ F filter capacitors. The value of these capacitors will depend directly on the output load and the length of the blank pulse. If synchronization to the system is desired, a system-derived 20 kHz square wave may be applied at C1's negative input through 2k, after removing the 300 pF capacitor and the 100k feedback resistor. The low noise during the blank pulse period affords ideal conditions for sensitive system operations. Although this approach allows great flexibility, the amount of off time is limited by the storage capacity of the output filter capacitors. In most systems this is not a problem, but some cases may require a converter which supplies low noise outputs at 100% duty cycles.

SINE WAVE DRIVEN CONVERTER

Figure 7 diagrams a converter which sacrifices the efficient saturated-switch mode of operation to achieve an inherently low noise output at a 100% duty cycle. In this converter, sine wave drive is used to power the transformer. Q1 functions as a 20 kHz phase shift oscillator with Q2 providing an emitter-followed output. A1 and A2 are used to drive the transformer in complementary-bridge fashion (traces A and B, Figure 8). The high current output capability of the amplifiers, in combination with the transformer's paralleled primaries, results in a high power transformer drive. The transformer output is rectified, filtered and regulated in the usual

fashion. Because the sine wave drive contains little harmonic content and current spiking, output noise is well below 1 mV (trace C, Figure 8). To adjust this circuit, ground the wiper arm of the 1k potentiometer and adjust the 100k value for minimum power supply drain. Next, unground the 1k potentiometer wiper arm and adjust it so that both A1 and A2's outputs are as large as possible without clipping. This circuit yields a low noise output on a 100% available basis but efficiency degrades to about 30%. In relatively low power converters such as this one (e.g., 50 mA output current) this is often acceptable.

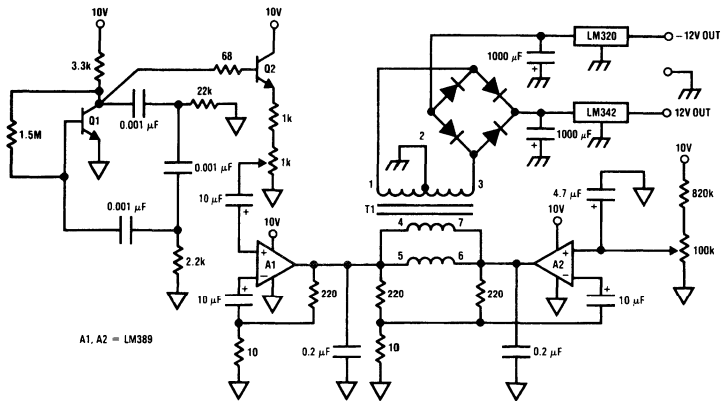


FIGURE 7

TL/H/7495-7

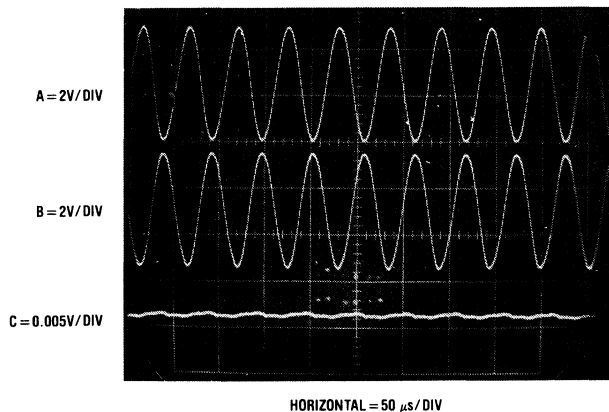


FIGURE 8

TL/H/7495-8

LOW POWER CONVERTER

Figure 9 shows a converter which operates from very low power. This circuit will provide 7.5V output from a 1.5V D cell battery. With a 125 μ A load current (typically 20 CMOS ICs) it will run for 3 months. It may be externally strobed off during periods where lowest output noise is desired and it also issues a "converter running" pulse. This circuit is unusual in that the amount of time required for Q1 and Q2 to drive the transformer is directly related to the load resistance. The converter's output voltage is sensed by an LM10 op amp reference IC, which compares the converter output to its own internal 200 mV reference via the 5.1M-160k voltage divider. Whenever the converter output is below 7.5V, the LM10 output goes high, driving the Q1-Q2 pair and the transformer which form an oscillator. The transformer output is rectified and used to charge the 47 μ F capacitor. When the capacitor charges to a high enough value, the

LM10 output goes low and oscillation ceases. Trace A, Figure 10 shows the collector of Q1, while trace B shows the output voltage across the 47 μ F capacitor (AC coupled). It can be seen that each time the output voltage falls a bit the LM10 drives the oscillator, forcing the voltage to rise until it is high enough to switch the LM10 output to its low stage. The frequency of this regulating action is determined by the load on the converter output. To prevent the converter from oscillating about the trip point, the 0.1 μ F unit is used to provide hysteresis of response. Very low loading of the converter will result in almost no on time for the oscillator while large loads will force it to run almost constantly. Loop operating frequencies of 0.1 Hz to 40 Hz are typical. The LM10 output state may be used to alert the system that the converter is running. A pulse applied to the LM10 negative input will override normal converter operation for low noise operation during a critical system A/D conversion.

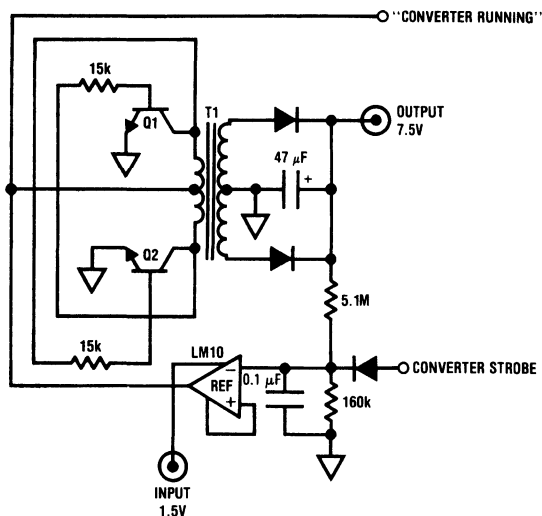


FIGURE 9

TL/H/7495-9

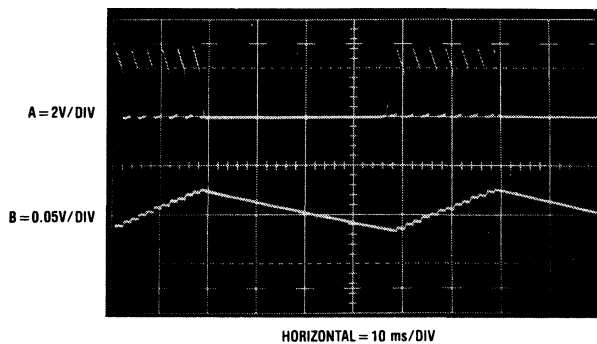


FIGURE 10

TL/H/7495-10

Circuit Applications Of Analog Data Multiplexers

National Semiconductor
Application Note 289



Although designers are familiar with analog multiplexers in data acquisition systems, relatively little use is made of these devices in circuit-oriented applications. This is unfortunate, because IC analog multiplexers combine features which allow a variety of circuit functions to be implemented. The combination of multi-contact analog commutation, differential or single-ended switching and fully decoded logic addressing achieves complex circuit functions with surprising ease. The position servo of *Figure 1* furnishes an excellent example.

POSITION SERVO

The circuit of *Figure 1* uses an LF11508 multiplexer in a position servo scheme. In this arrangement the motor shaft may be programmed to stop at 8 discrete positions. Each

position is fully programmable and any shaft position may be accessed in any sequence. Assume power has just been applied and the output of the 74C90 counter is "0000". This condition forces the LF11508 to close the switch associated with Pot #1's ("P1") wiper arm. The difference between P1's wiper potential and the 5k "pick-off" servo potentiometer is amplified by A2. The A1 followers unload the potentiometer outputs. A2's output is compared by the remaining A1 amplifiers, which are configured as a dual-limit comparator with deadband. Depending upon the polarity of A2's output, the appropriate comparator saturates high, turning on its associated driver transistor. This drives the motor in the necessary direction to force a null at A2's output. When the null falls within the diode-generated .6-volt deadband, both comparator outputs will be low and the motor will stop.

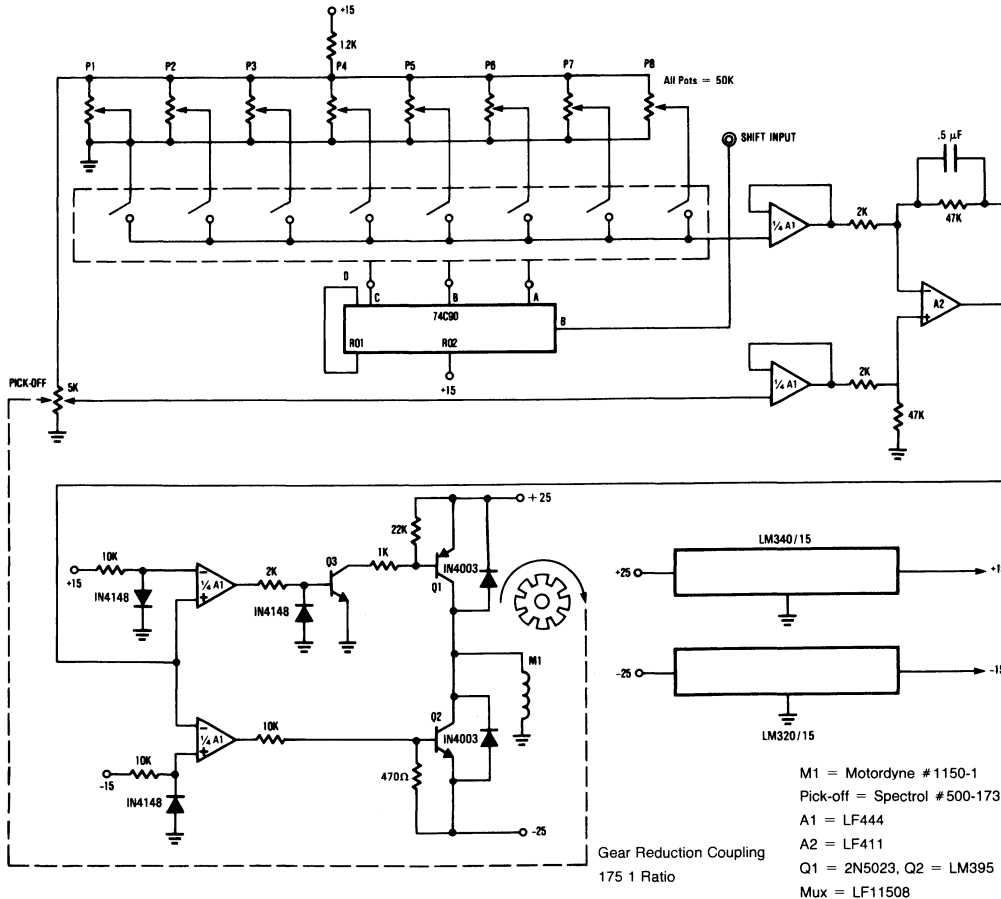
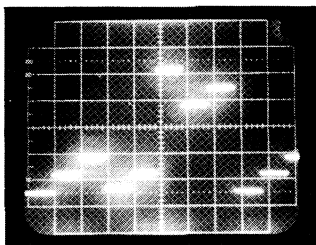


FIGURE 1

TL/H/5635-1

Vertical = 2V/Div.



Horizontal = .2 sec/Div.

FIGURE 2

TL/H/5635-2

A2, operating at a gain of 30, provides adequate gain for precise positioning while the ± 25 -volt supplies and the motor-gearbox combination achieve good speed. The $.5\mu\text{f}$ capacitor at A2 sets the loop roll-off.

Each time a pulse is applied to the "shift input," the multiplexer advances to the next position, closing the appropriate switch and forcing the servo to seek the position dictated by the potentiometer output. Because all potentiometers

may be set to any potential, any desired positioning pattern may be obtained. Figure 2, a stored trace display of the multiplexer output bus, shows the servo at work. The photo shows that eight discrete positions are selected in a dispersed, non-monotonic fashion. Any desired positioning sequence can be obtained by appropriate setting of the potentiometers. This circuit requires no voltage reference because the pick-off and position setting potentiometers are driven from the same source. In addition, because the shaft position program is "stored" in the potentiometer settings, the circuit requires no power-up initialization or sequencing.

TTL PROGRAMMABLE GAIN INSTRUMENTATION AMPLIFIER

Figure 3 depicts an instrumentation-type amplifier. The gain and frequency response may be programmed via TTL inputs. In this circuit, an LF11509 differentially-switched multiplexer is used to select the feedback resistors for A1 and A2. One-half of A3 is used to single-end the differential outputs of A1 and A2 at a gain of ten. A low-pass filter is formed by whatever resistor is connected to the $1\mu\text{f}$ capacitor via the LF13331 analog switches. This filter's output is buffered by the other half of A3 and presented as the circuit's output. The LM11s in the front end give this circuit $2\mu\text{V}/^\circ\text{C}$ drift performance while CMRR of 100dB is obtainable with good resistor matching. Gain and bandwidth programming data are summarized in the tables shown in Figure 3.

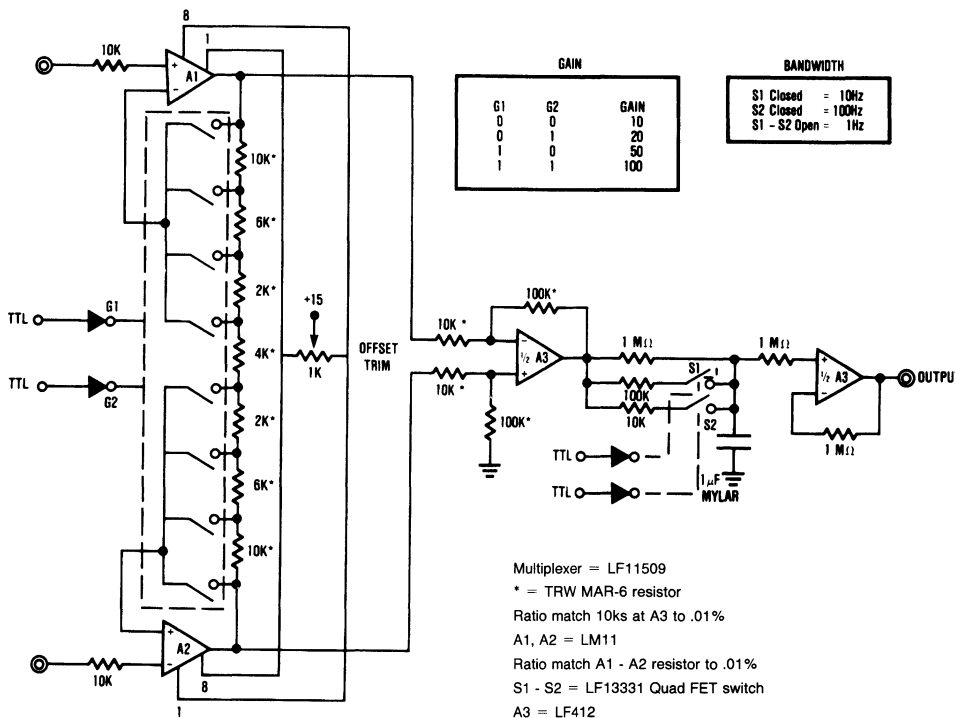


FIGURE 3

TL/H/5635-3

PROGRAMMABLE SAMPLE-HOLD AMPLIFIER

A differential input multiplexer is used to program the acquisition time and droop-rate characteristics of a sample-and-hold amplifier in *Figure 4*. In this circuit, one-half of the differential input LF13509 multiplexes four inputs to the LF398 sample-and-hold amplifier. The other half of the multiplexer is used to select the "hold-capacitor." Because one address code simultaneously switches both multiplexer halves, any desired hold-capacitor value can be used for any input combination. The attendant droop-rate acquisition-time performance range (see table in *Figure 4*) allows a very wide range of input signals to be handled.

SINGLE-PULSE SAMPLER

Figure 5 shows a circuit which captures a low repetition rate or single-shot waveform and presents it as a repetitive display on an oscilloscope. The display rate may be set to any desired value. Circuit operation is triggered by the event of interest. When the monitored event occurs (trace A, *Figure 6*), A1, an LM311 comparator, triggers low (trace B, *Figure 6*). This allows the 15k-1200pF RC combination at A2 to charge (waveform C, *Figure 6*), and A2's output is a pulse train (waveform D, *Figure 6*). Each pulse out of A2 is used to advance the 74C90 counter by one step. The 74C90's BCD output is fed to the 74C42, which decodes it into 8 discrete sequential outputs. These outputs are used once to trigger individual LF398 sample-and-hold amplifiers. In this manner, each individual sample-and-hold amplifier acquires a fraction of

the waveform of interest. When the input waveform ceases, A1's output returns high, A2 stops emitting pulses and no further circuit action occurs. At this time, the 8 sample-and-hold amplifiers contain all the amplitude information necessary to reconstruct the original input waveform. This is accomplished by driving the clock input with a pulse train which is counted and presented to the LF11508 multiplexer address inputs by another 74C90. The multiplexer output bus is followed by A3, providing the circuit's output. As the multiplexer steps through its 8 states, the sampled and reconstructed version of the input waveform appears in a steady, repetitive display (trace E, *Figure 6*). The clock frequency may be varied to allow any desired oscilloscope sweep speed to be used.

AUTOMATIC, SELF-CALIBRATING STRAIN GAUGE READOUT

Figure 7 uses an LF13509 differential multiplexer in an auto-calibration arrangement, which eliminates almost all errors in a strain gauge load cell transducer measurement. Errors due to drift with time and temperature are cancelled and individual transducers may be interchanged with no manual gain or zero recalibration required. In this system, 4 discrete operations are performed in order to determine the corrected output of the load cell. The start of a measurement cycle is initiated by the microprocessor commanding the LF13509 differential input multiplexer to position 1. In this position, the strain gauge bridge output is connected to the LH0038 instrumentation amplifier.

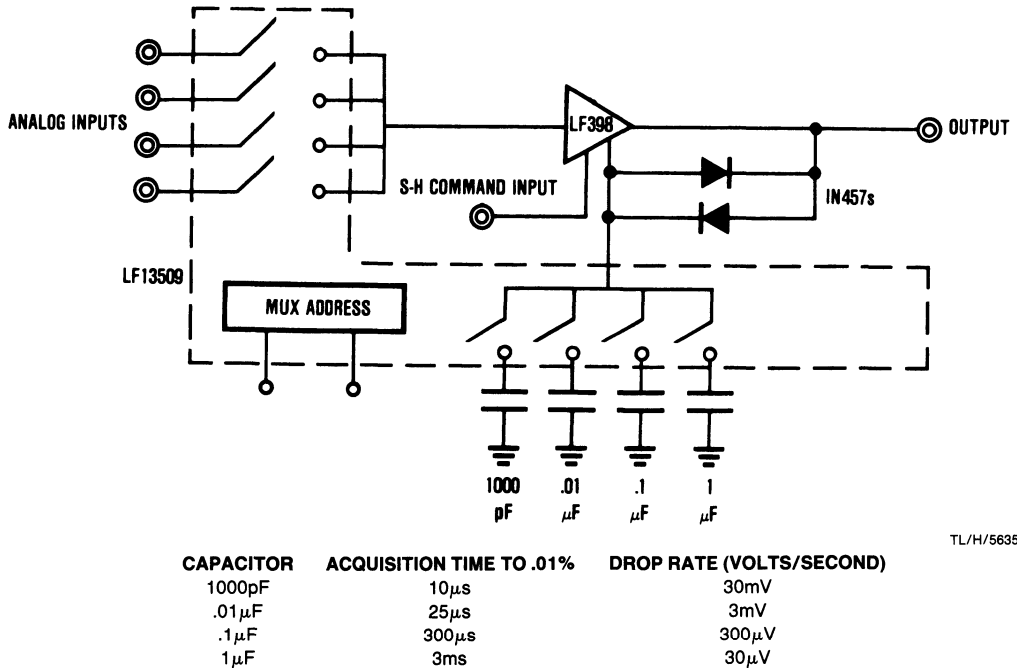


FIGURE 4

TL/H/5635-4

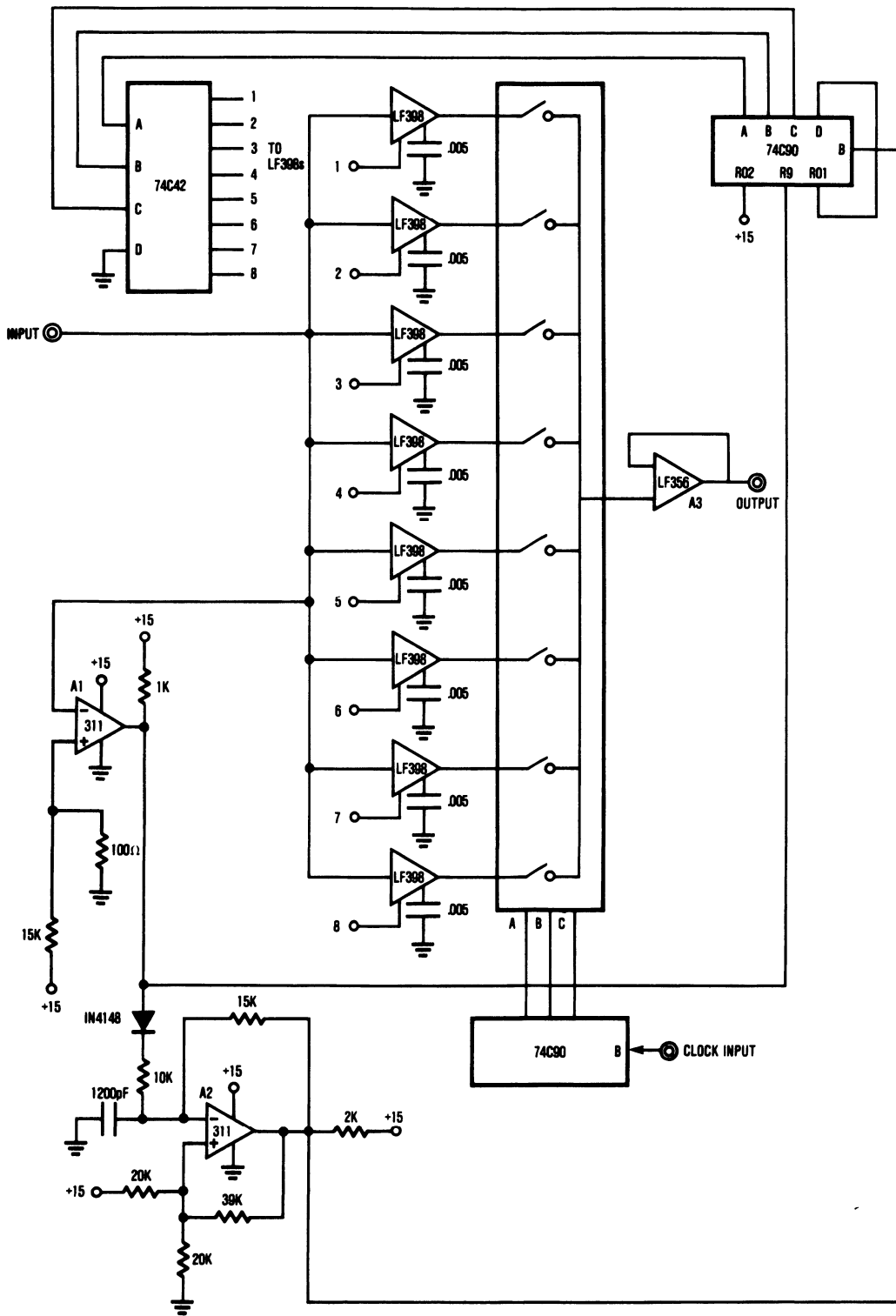


FIGURE 5

TL/H/5635-5

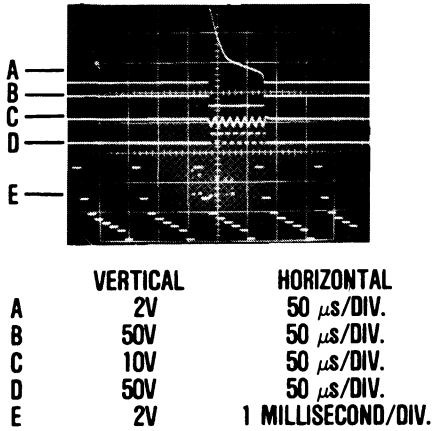
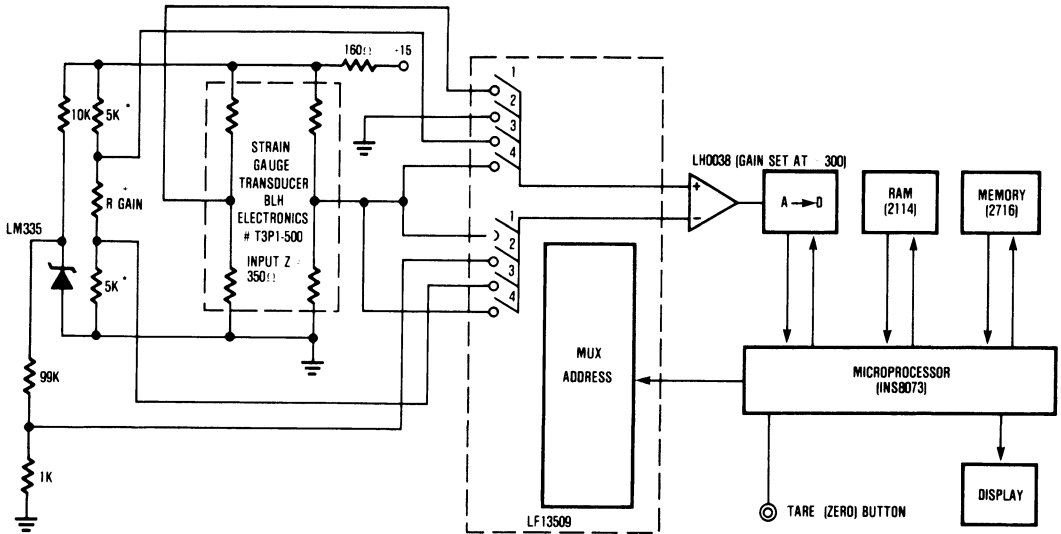


FIGURE 6

TL/H/5635-6

This signal, which represents the transducer output, is amplified by the LH0038, converted by the A/D and stored in memory. The multiplexer is then switched to position 2. In this position, the output of the LM335 temperature sensor, which is located inside the load cell transducer, is determined and stored in memory. The relatively high-level LM335 output is resistively divided by 100 so the LH0038 does not saturate. When this measurement is completed, the multiplexer switches to position 3. In this position, the LH0038 inputs are connected across the middle resistor in a string of resistors. The voltage across this resistor represents the *precise* full-scale output voltage of the load cell transducer. This information allows the system to determine the gain slope of the transducer. In practice, the middle resistor in the string is physically located within the load cell connector. When any such equipped load cell is plugged into the system, the value of this resistor allows immediate and precise gain-slope compensation and eliminates the usual calibration requirements. The final position of the multiplexer connects the amplifier inputs to one side of the bridge. This determines the electrical zero in the system at the common mode output voltage of the strain gauge bridge.



TL/H/5635-7

- * = ULTRONIX 105A
.01%
- + = SELECTED VALUE
TYPICAL 33.4 Ω
ULTRONIX 105A

FIGURE 7

Physical zero information, e.g., "tare weight," is fed to the microprocessor via a push button which is depressed when no load is on the transducer. This operation need only be carried out when the system is first turned on. At this point, the microprocessor has values for zero, strain bridge output, precise full-scale output for the particular transducer in use, as well as transducer temperature and initial tare weight. Using this information, the microprocessor can determine the precise load on the transducer, regardless of drifts or initial individual transducer gain-slope tolerances. The temperature information provides a first-order correction for the relatively small effect of ambient temperature on gain slope and zero, while the gain resistor in the load cell allows complete interchangeability of load cells with no field calibration at all. The stability of this approach is entirely dependent on the resistors in the gain calibration string. The voltage drive to the bridge need not be stable, because it is common to the gain calibration string and ratio-metrically cancels. Multiplexer-fed systems of this type have achieved 1 part in 20,000 repeatability in industrial environments.

Programmable Waveform Generator

Figure 8 diagrams a way of using the 8-channel LF13331 multiplexer to generate a 32-piece approximation of a desired waveform. In this instance, a sine wave is used as an

example. When pulses are applied to the clock input, the logic circuitry instructs the multiplexer to count up to 8 (74C193 count "up" and "down" inputs are traces A and B in Figure 9). When this operation is completed, the multiplexer is instructed to count down to zero. The logic then inverts the voltage supplied to the potentiometers at the multiplexer inputs. This is accomplished by grounding the positive input of the LF412 amplifier with LF13331 FET switch. This forces the LF412 output (trace C, Figure 9) to negative 6.9 volts. Concurrently, the logic instructs the multiplexer to count up to 8 and back down. At this point, the output of the LF412 is forced to positive 6.9 volts by turning off the LF13331, and the entire cycle repeats. If the potentiometers are set appropriately, a sine wave approximation of 32 steps results (trace D, Figure 9) at the circuit output. The filtered output of this waveform (trace E, Figure 9) contains less than .5% distortion (trace F, Figure 9). If the potentiometer outputs are deliberately mis-set, any form of sine wave distortion may be intentionally generated by lab work or listening tests, Figure 10 shows the circuit output (trace A) under these conditions. Trace B, the filtered, output, is a good approximation of severe harmonic distortion. Trace C, the output of a distortion analyzer, indicates almost 7% distortion. The type and level of distortion, e.g., clipping, crossover, etc., may be programmed by adjusting the potentiometers.

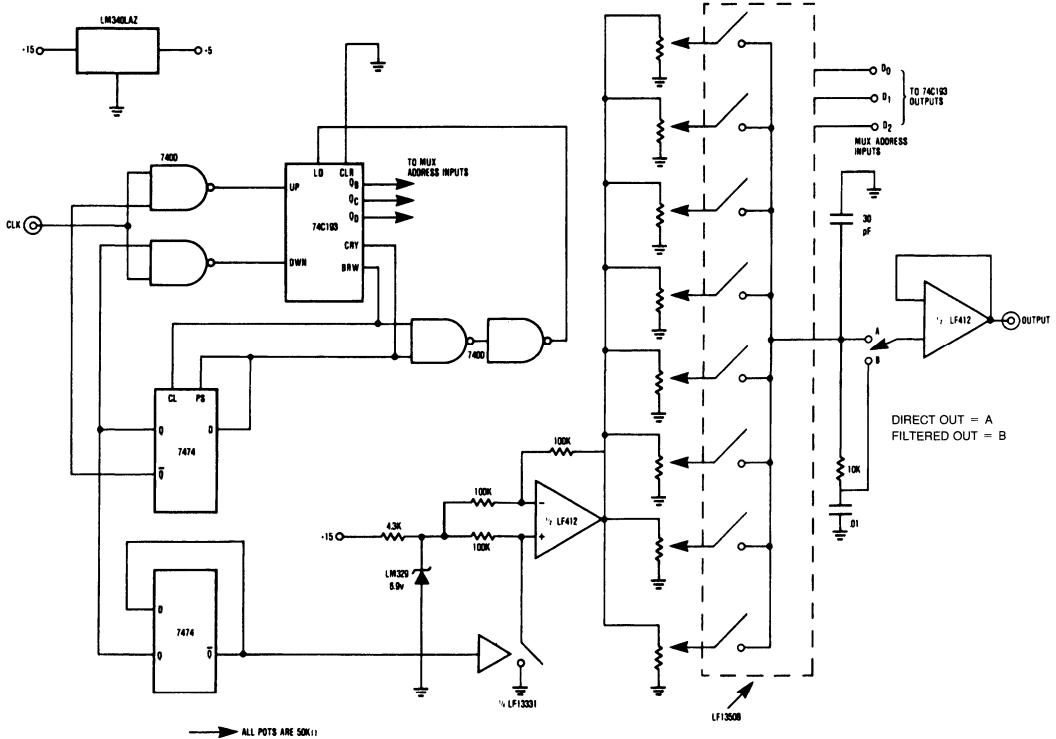


FIGURE 8

TL/H/5635-8

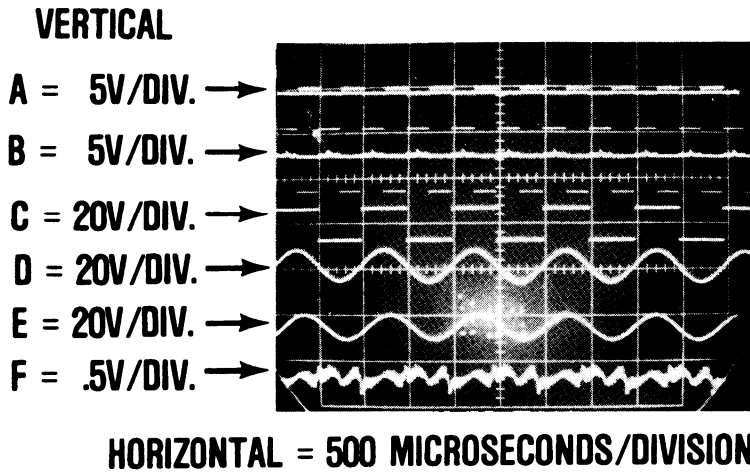


FIGURE 9

TL/H/5635-9

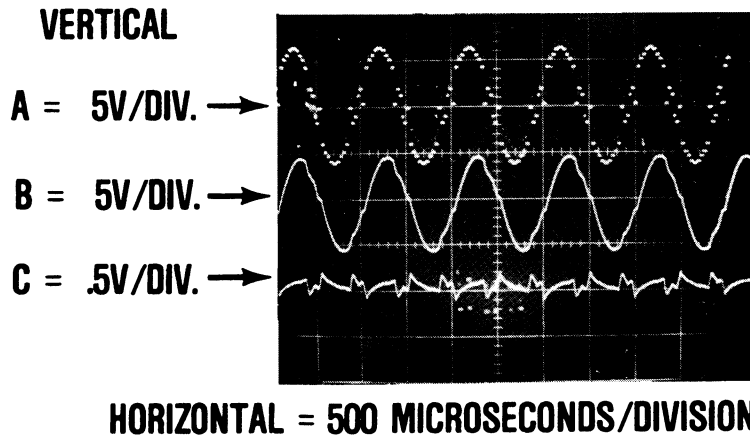


FIGURE 10

TL/H/5635-10

Applications of the LM3524 Pulse-Width-Modulator

National Semiconductor
Application Note 292
Jim Williams



The LM3524 Regulating Pulse-Width-Modulator is commonly used as the control element in switching regulator power supplies. This is in keeping with its intended purpose. Engineers closely associate this part with switching power supplies. Nevertheless, the flexible combination of elements (see box) within the LM3524 also allows it to be used in a number of other applications outside the power supply area. Because the device is inexpensive and operates off a single-sided supply, it can considerably reduce component count and circuit complexity in almost any application. The constant light intensity servo of *Figure 1* furnishes a good example.

CONSTANT LIGHT INTENSITY SERVO

The circuit of *Figure 1* uses a photodiode's output to control the intensity of a small light bulb. The constant intensity output of the light bulb is useful in a number of areas, including opto-electronic component evaluation and quality control of photographic film during manufacture. In this circuit, the photodiode pulls a current out of the LF356 summing

junction, which is directly related to the amount of light that falls on the photodiode's surface. The LF356 output swings positive to maintain the summing junction at zero and represents the photodiode current in amplified voltage form. This potential is compared at the LM3524 to the voltage coming from the 2.5k "intensity" potentiometer wiper. A stable voltage for the "intensity" control is taken from the LM3524's internal five-volt regulator. The difference between the LF356 output and the "intensity" potentiometer output is amplified at a gain of about 70 dB, which is set by the 1 M Ω value at pin 9. The LM3524 output transistors are paralleled and provide drive to the 2N2219 switch transistor. The 5.6k and .01 μ F values set the switching frequency at about 30 kHz. Because the LM3524 forms a switched mode feedback loop around the light bulb and photodiode, the average power delivered to the light bulb will be controlled by the photodiode output, which is directly proportional to the lamp's output. Frequency compensation for this feedback loop is provided by the .001 μ F capacitor, which rolls off the loop gain at a 1 ms time constant. *Figure 2* shows the wave-

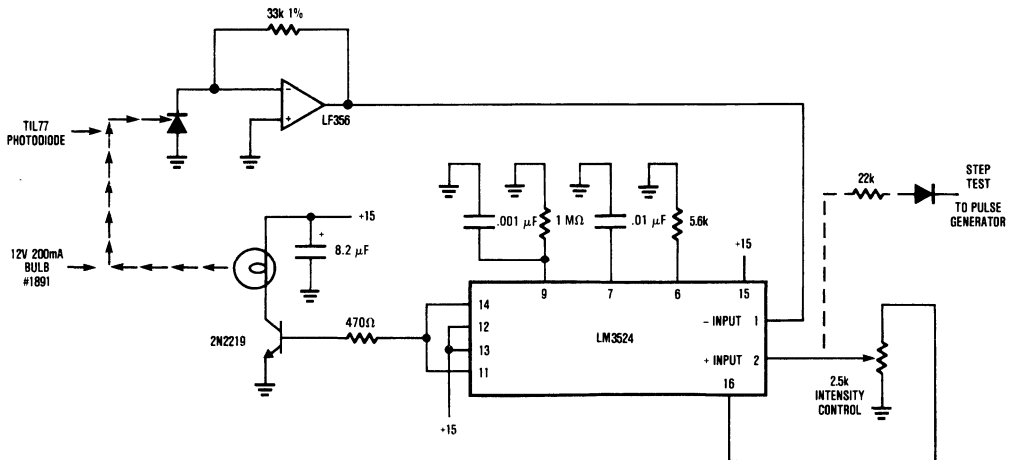


FIGURE 1

TL/H/6890-1

forms in the circuit. Trace A is the 2N2219 collector and trace B is the AC-coupled LF356 output. Each time the 2N2219 collector goes low, power is driven into the lamp. This is reflected in the positive going ramp at the LF356's output. When the 2N2219 goes off, the lamp cools. This is shown in the negative going relatively slow ramp in trace B. It is interesting to note that this indicates the bulb is willing to accept energy more quickly than it will give it up. *Figure 3a* elaborates on this. Here, trace A is the output of a pulse generator applied to the "step test" input and trace B is the AC-coupled LF356 output. When the pulse generator is high, the diode blocks its output, but when it goes low, current is drawn away from the "intensity" control wiper through the 22k resistor. This forces the servo to control bulb intensity at a lower value. This photo shows that the bulb servos to a higher output almost three times as fast as it takes to go to the lower output state, because the bulb more readily accepts energy than it gives it up. Surprisingly, at high intensity levels, the situation reverses because the increased incandescent state of the bulb makes it a relatively efficient radiator (*Figure 3b*).

TEMPERATURE-TO-PULSE-WIDTH CONVERTER

The circuit in *Figure 4* uses the LM3524 to convert the output of an LM135 temperature transducer into a pulse width which can be measured by a digital system, such as a microprocessor-controlled data acquisition system. Although this example uses the temperature transducer as the input, the circuit will convert any 0.1 to 5V input applied to the 100 kΩ resistor into a 0–500 ms output pulse width with 0.1% linearity. In this circuit, the LM135's temperature-dependent output (10 mV/°K) is divided down and applied to A1's positive input. This moves A1's output high, driving the input to the LM3524's pulse-width modulation circuitry. The LM3524 pulse-width output is clipped by the LM185 reference and integrated by the 1 MΩ-0.1 μF combination. The DC level across the 0.1 μF capacitor is fed back to A1's negative input. This feedback path forces the LM3524's output pulse

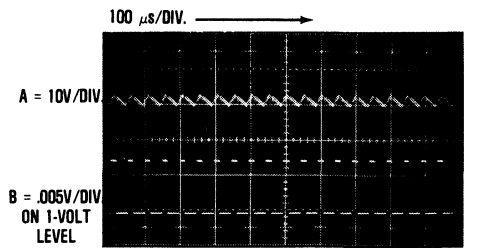


FIGURE 2

TL/H/6890-2

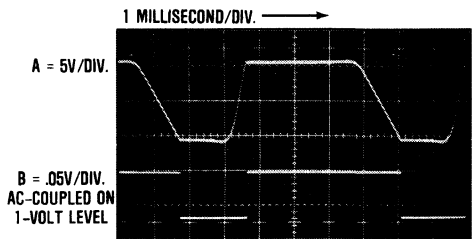


FIGURE 3a

TL/H/6890-3

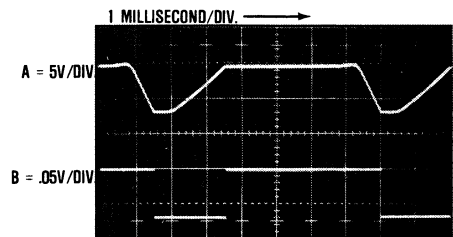
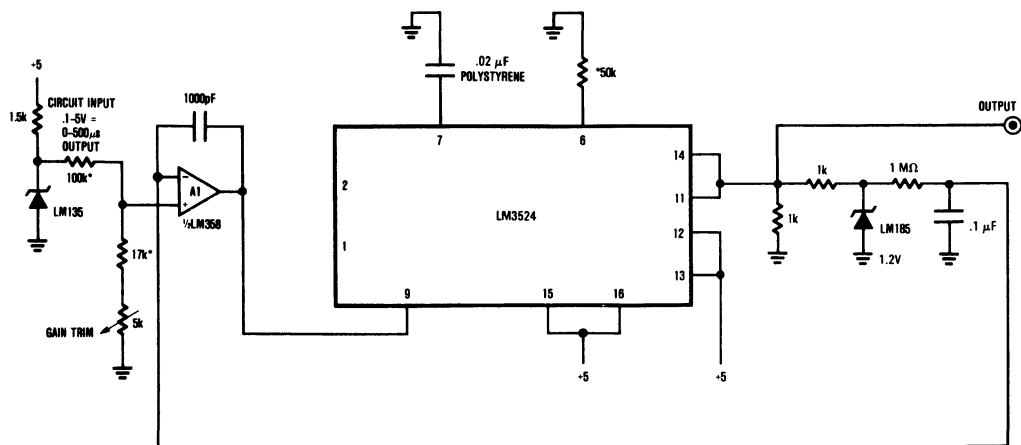


FIGURE 3b

TL/H/6890-4



*Metal Film Resistor

FIGURE 4

TL/H/6890-5

width to vary in a highly linear fashion according to the potential at A1's positive input. The overall temperature-to-pulse width scale factor is adjusted with the "gain trim" potentiometer. The 1000 pF capacitor provides stable loop compensation. A1, an LM358, allows voltages very close to ground to be sensed. This provides greater input range than the LM3524's input amplifier, which has a common mode range of 1.8–3.4V. The oscillator output pulse at pin 3 may be used to reset counters or other digital circuitry because it occurs just before the output pulse width begins.

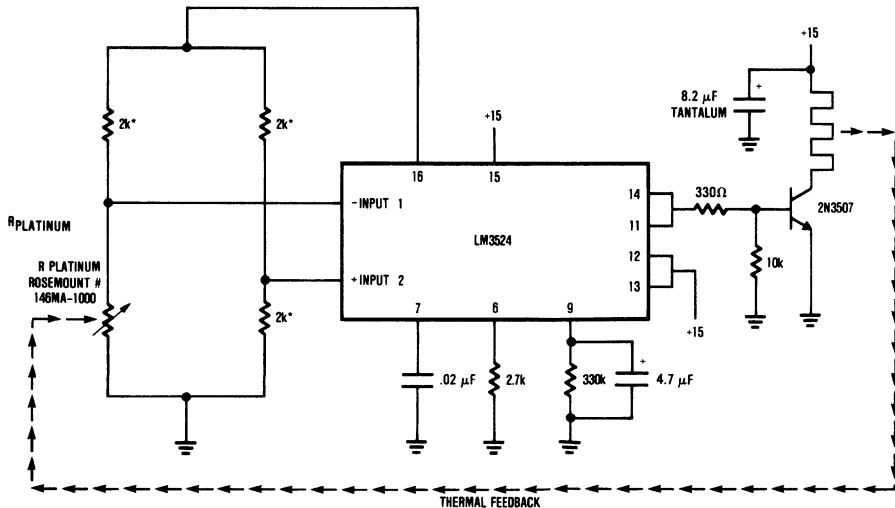
RTD TEMPERATURE CONTROLLER

Figure 5 is another temperature circuit which uses the LM3524 to control the temperature of a small oven. Here, a platinum RTD is used as a sensor in a bridge circuit made up of the 2 k Ω resistors. When power is applied, the positive temperature coefficient platinum sensor is at a low value and the LM3524's positive input is at a higher potential than its negative input. This forces the output to go high, turning on the 2N3507 and driving the heater. When the servo point is reached, the duty cycle of the heater is reduced from 90% (full on) to whatever value is required to keep the oven at temperature. The 330k-4.7 μ F combination at the internal input amplifier's output sets the servo gain at about 55 dB at 1 Hz, more than adequate for most thermal-control appli-

cations. The 0.02 μ F-2.7k combination sets the pulse frequency at about 15 kHz, far above the 1 Hz pole of the servo gain. If the sensor is maintained in close thermal contact with the heater, this circuit will easily control to .1°C stability over widely varying ambients.

"SENSORLESS" MOTOR SPEED CONTROL

Figure 6 shows the LM3524 in an arrangement which controls the speed of a motor without requiring the usual tachometer or other speed pick-off. This circuit uses the back EMF of the motor to bias a feedback loop, which controls motor speed. When power is applied, the positive input of the LM3524 is at a higher potential than the negative input. Under these conditions, the output of the LM3524 is biased full on (90% duty cycle). The output transistors, paralleled in the common emitter configuration, drive the 2N5023 and the motor turns. (LM3524 output is waveform A, Figure 7; waveform B is the 2N5023 collector.) The LM3524 output pulse is also used to drive a 1000 pF-500 k Ω differentiator network whose output is compared to the LM3524's internal 5V reference. The result is a delayed pulse (Figure 7, waveform D), which is used to trigger an LF398 sample-and-hold IC. As the waveforms show, the sample-and-hold is gated high (ON) just as the 2N5023 collector stops supplying current to the



*TRW Type MAR-60 .1%

FIGURE 5

TL/H/6890-6

motor. At this instant, the motor coils produce a flyback pulse, which is damped by the shunt diode. (Motor waveform is *Figure 7*, trace C). After the flyback pulse decays, the back EMF of the motor remains. This voltage is "remembered" by the sample-hold IC when the sample trigger pulse ceases and is used to complete the speed control loop back at the LM3524 input. The 10k-4k divider at the motor output insures the LF398's output will always be within the common range of the LM3524's input. The 10k-1 μF combination provides filtering during the time the LF398 is sampling. The diode associated with this time constant

prevents any possible LF398 negative output from damaging the LM3524. The 10 M Ω resistor paralleling the 0.01 μF sampling capacitor prevents the servo from "hanging up" if this capacitor somehow manages to charge above the motor's back EMF value. The 39k-100 μF pair sets the loop frequency response. The maximum pulse-width-modulator duty cycle is clamped by the 2k-2k divider and diode at 80%, thus avoiding overshoot and aiding transient response at turn-on and during large positive step changes. The 60k-0.1 μF values at pins 6 and 7 set the pulse modulation frequency at 300 Hz.

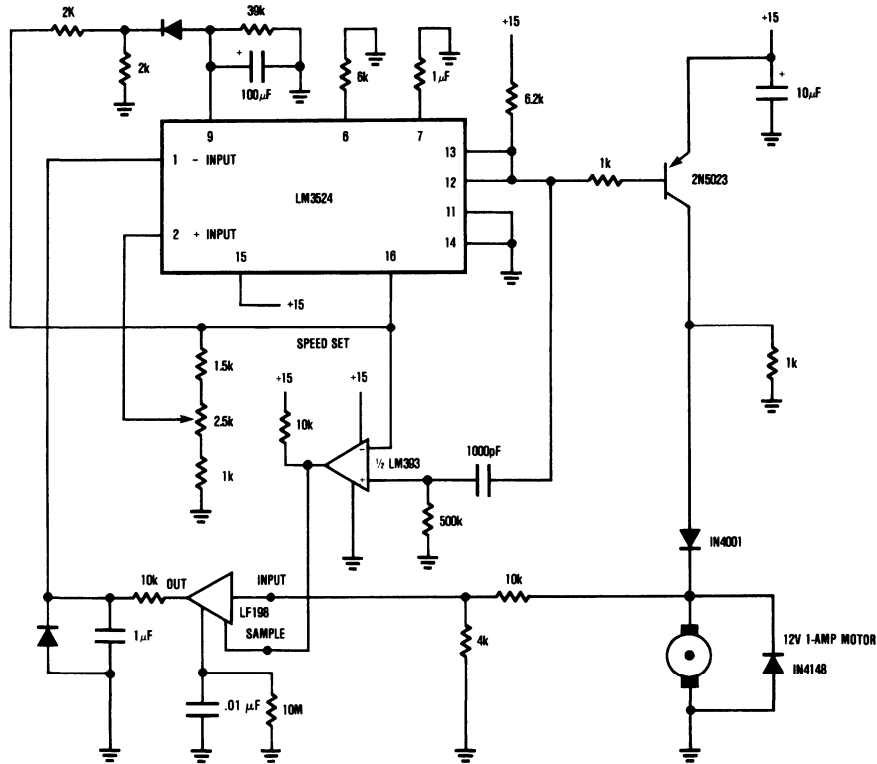


FIGURE 6

TL/H/6890-7

HORIZONTAL = 3 μs /DIV.

- A = 20V/DIV.
- B = 10V/DIV.
- C = 50V/DIV.
- D = 20V/DIV.

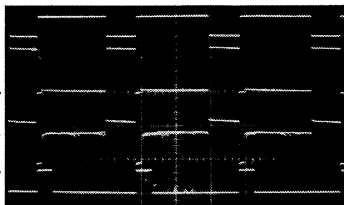
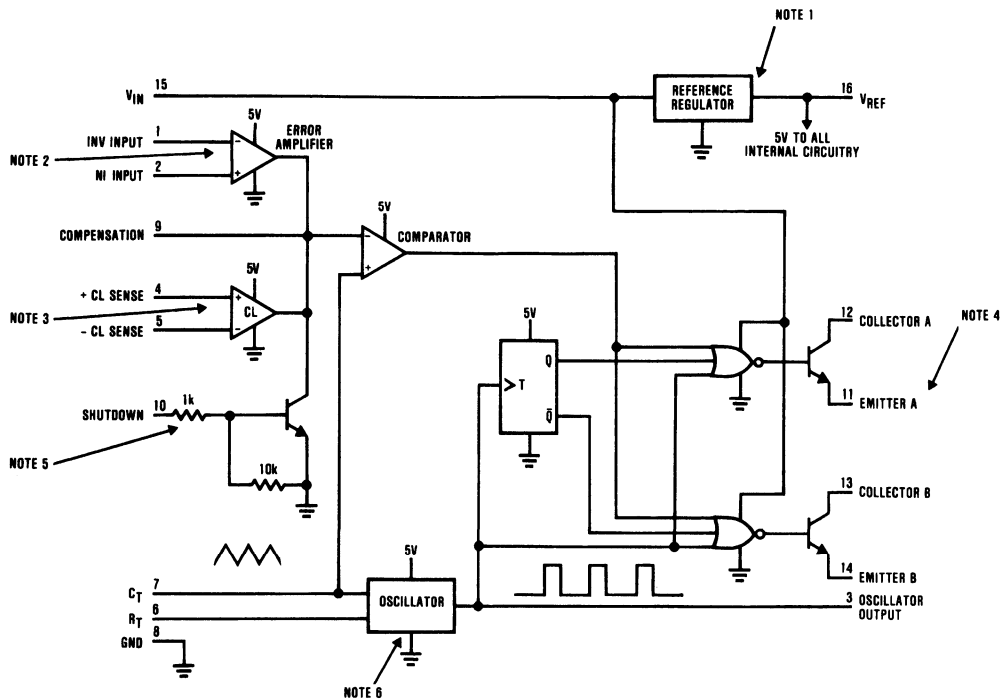


FIGURE 7

TL/H/6890-8

The LM3524 at a Glance



TL/H/6890-9

- Note 1:** 5V 50 mA regulator available to user.
- Note 2:** Transconductance diff. input amplifier. Gains from 40-80 dB available by resistor loading of output. 1.8-3.4V common mode input range.
- Note 3:** Over current sense comparator -0.7 to 1V common mode input range.
- Note 4:** Output transistors switch out of phase and may be paralleled. Up to 100 mA maximum output current.
- Note 5:** Transistor may be used to strobe LM3524 into an off state at its outputs.
- Note 6:** Oscillator typically frequency programmable for up to 100 kHz.

Control Applications of CMOS DACs



The CMOS multiplying digital-to-analog converter can be widely applied in processor-driven control applications. Because these devices can have a bipolar reference voltage their versatility is increased. In some control applications the DAC's output capabilities must be substantially increased to meet a requirement while others require substantial additional circuitry to drive a transducer or actuator. A good example of the latter is furnished by *Figure 1*.

SCANNER CONTROL

Biochemists use a procedure called "scanning electrophoresis" to separate cells from each other. In one form of this process the sample is contained within a vertical glass or quartz tube approximately 1 foot in length. When a high voltage potential is applied across the length of the tube the cells separate along the charge density gradient which runs along the tube's length. This results in a series of stripes

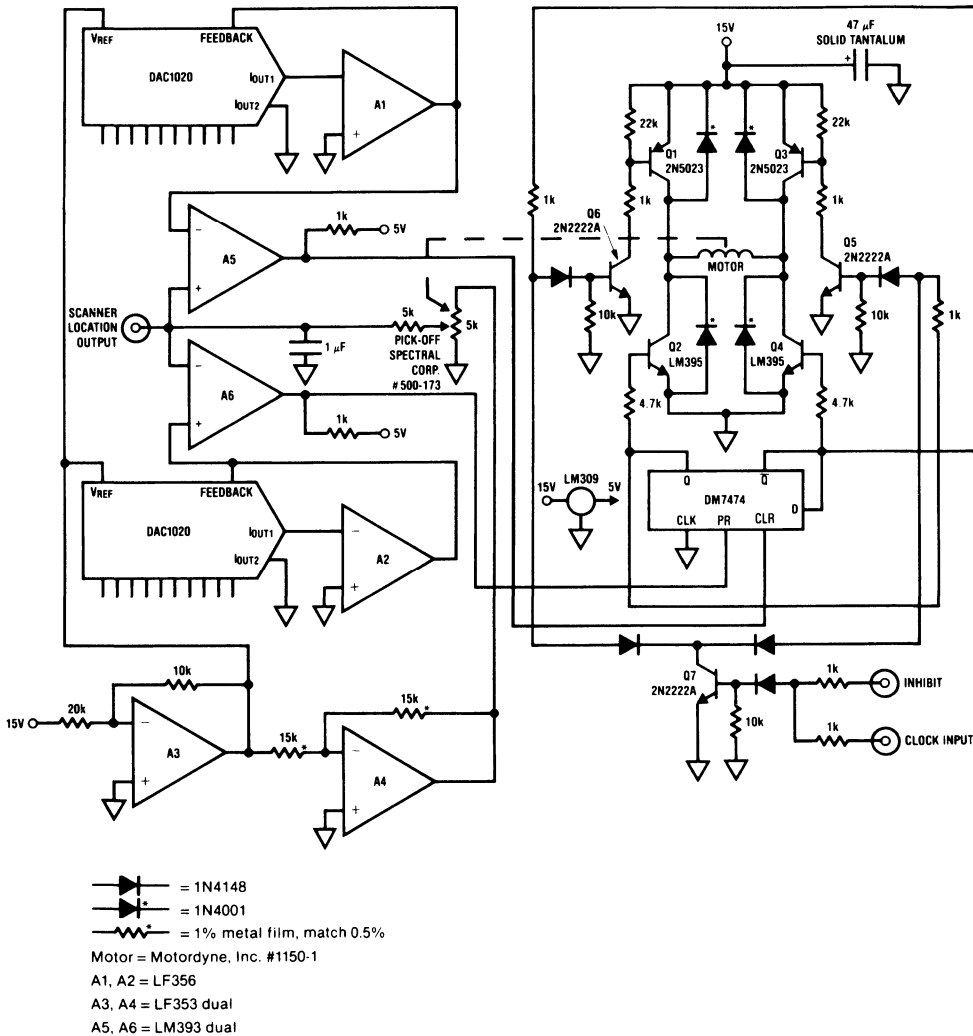


FIGURE 1

TL/H/5636-1

or bands within the tube as the individual cells, under the influence of the charge gradient, collect together. When separation is complete, the tube is mechanically scanned along its length by a photometer for optical density characteristics of each band. This information yields useful biochemical information to the experimenter. The scanner must be fully programmable so that it can be run between any two limits at a variety of speeds. In Figure 1 the two DAC1020 D/A converters establish the limits of the scan. The 5k pick-off potentiometer furnishes scanner location information and the motor drives the scanner (via a gear-train). A5 and A6 are comparators, one of whose outputs goes low when either the high limit (A6 and its associated DAC) or low limit (A5 and its associated DAC) is exceeded. A1 and A2 furnish voltage outputs from the current output of the DACs. A3 and A4 are used to provide suitable reference voltages for the 5k pick-off potentiometer and the DAC reference inputs.

The DM7474 flip-flop is configured in a set-reset arrangement which changes output state each time either A5 or A6 goes low. When the lower limit of the scan is reached, A5

goes low, setting the DM7474's Q output too high. This turns on Q2, Q5 and Q3 resulting in current flow through the motor from Q3 to Q2. This forces the scanner to run towards its high limit. When this limit is reached, A6 goes low and the flip-flop changes state. This turns off the Q2, Q5, Q3 combination and the Q4, Q6, Q1 trio come on, forcing current through the motor in the opposite direction via the Q1-Q4 path. This causes the motor to reverse and proceed toward the lower limit. Q7 is driven by a width-modulated pulse train from the processor which is used to control the scanner's speed via Q5 and Q6. The diodes across Q1, Q2, Q3 and Q4 provide motor spike suppression and the internal current limiting in the LM395s (Q2-Q4) assures short circuit protection.

HIGH VOLTAGE OUTPUT FOR ATE

Testing high voltage components with automatic test equipment (ATE) is often inconvenient because a source of stable, controllable high voltage is required. Adding this capability to a piece of equipment can be expensive and time consuming if standard techniques are used. In Figure 2 a circuit is shown which has been employed in the testing

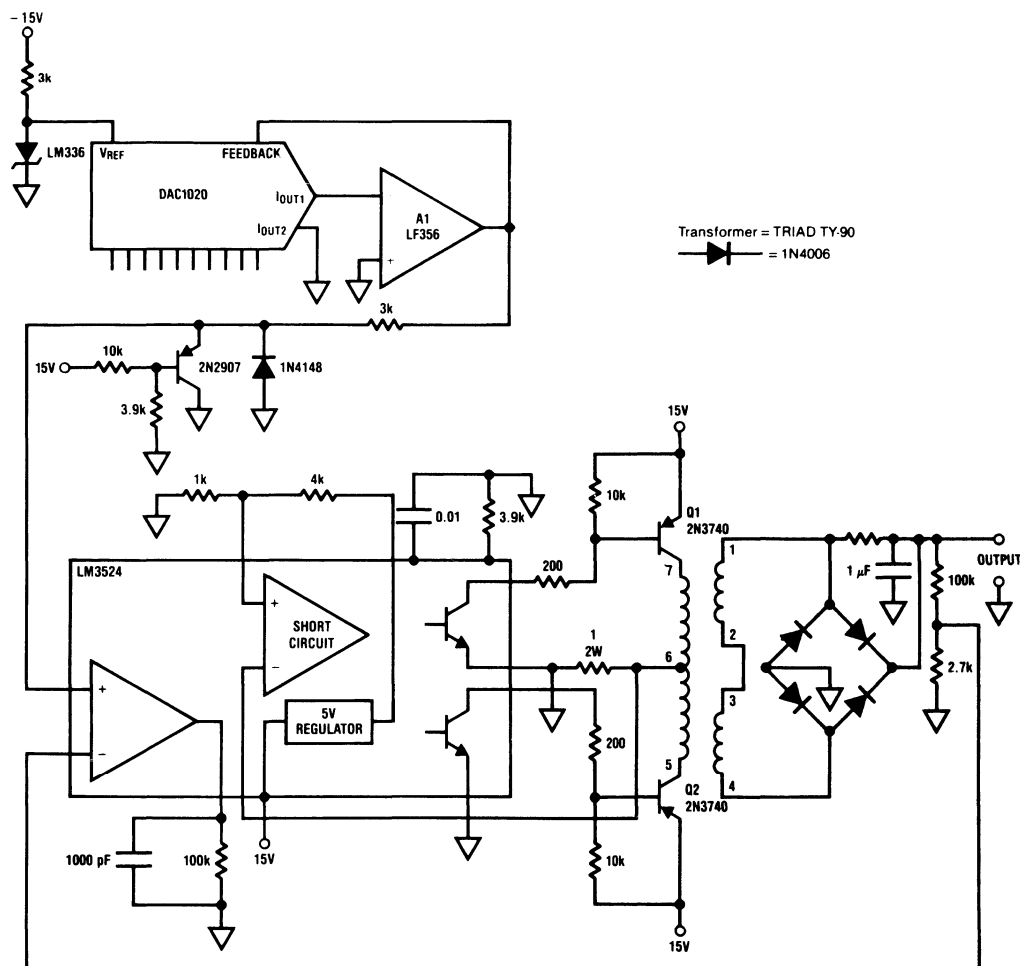


FIGURE 2

TL/H/5636-2

of high voltage transistors and zeners as well as fuse link blowing in PROMs. In this circuit, a high voltage output is developed by using a Toroidal DC-DC converter within a DAC-controlled pulse-width modulated feedback loop to obtain high voltage. The DAC1020 in conjunction with A1 supplies a setpoint to the LM3524 regulating pulse-width modulator. This set point needs to be within the LM3524's common mode input voltage range of 1.8V to 3.5V. The LM3524's outputs are used to drive the TY-90 toroid via Q1 and Q2. The high voltage square-wave transformer output is rectified and filtered and divided down by the 100k-2.7k string. This potential is fed back to the LM3524, completing a loop. Loop gain and frequency compensation are set by the 1000 pF-100k parallel combination, and the 1Ω resistor at pin 6 of the transformer is used to sense current for short circuit protection. Although the update rate into the DAC can be very fast, the 20 kHz switching of the transformer and the loop time constants determine the available bandwidth at the circuit's output. In practice, a full output sine wave swing of 100V into 1000Ω is available at 250 Hz.

PLATE-DRIVING DEFLECTION AMPLIFIER

Another common high voltage requirement involves deflection plate modulation in CRT and electron-optics applications. Figure 3 shows a pair of DAC1218s used to control both the static (DC) and dynamic (AC) drive to deflection plates in a piece of electron-optic equipment. In contrast to the previous high voltage circuit, this one has very little output current capability but greater bandwidth. The deflection plate load can be modeled as a 50 pF capacitor. In this application, the output of both DAC-amplifier pairs is summed at A3. In practice, one DAC will supply a DC level to the plate (bias) while the other one provides the plate's

AC signal, typically a ramp. The high voltage plate drive is furnished by the Q1, Q2, Q3, Q4 configuration which is a complementary common-base-driven common-emitter output stage. Because the output current requirements are low, the usual crossover distortion problems may be avoided by returning the circuit's output to negative supply via the 120 kΩ resistor. This eliminates notch compensation circuitry and results in a simplified design. Because the high voltage stage inverts, overall negative feedback is achieved by returning the 1 MΩ feedback resistor to A3's positive input. The point now becomes the summing junction for both DAC-driven inputs and the feedback signal. The output of this circuit is clean and quick, as shown in Figure 4. In this figure, 2 complete DAC-driven amplifiers were used to produce the traces. Trace A is the output of A1, while the complementary high voltage outputs are shown in B and C.

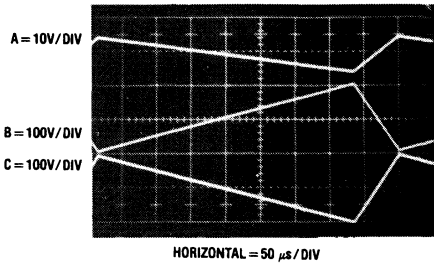


FIGURE 4

TL/H/5636-3

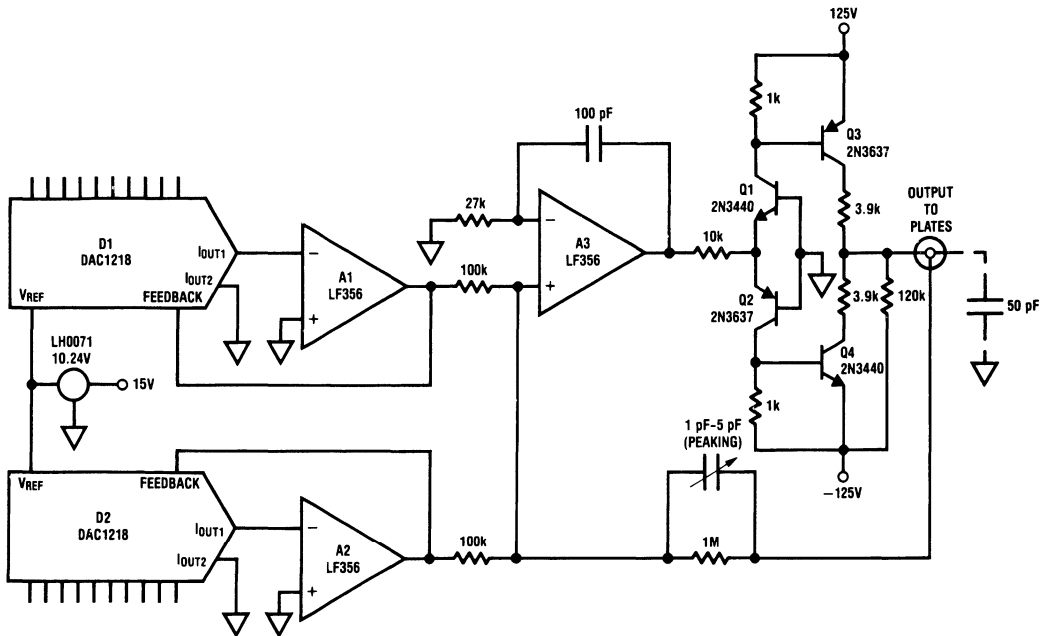


FIGURE 3

TL/H/5636-4

TEMPERATURE LIMIT CONTROLLER

Certain biochemical reactions occur only within very specific temperature limits. The behavior of these reactions within and at the edges of these limits is of interest to biochemists. In order to study these reactions, a special temperature control scheme is required. To meet this requirement, the circuit of *Figure 5* has been employed. In this circuit A1, A3, A4 and A5 comprise a simple pulse-width modulating temperature controller. A4 is an integrator that generates a ramp which is periodically reset to zero by the 10 kHz clock pulse. This ramp is compared to A3 output by A5, which biases the LM395 switch to control the heater. A3's output will be determined by the difference between the temperature setpoint current through the 22.6 k Ω resistor and the

current driven by the LM135 temperature sensor through the 10 k Ω resistor. Thermal feedback from the heater to the LM135 completes the loop. The 10M-1 μ F values at A3 set loop response at 0.1 Hz.

Up to this point, the circuit functions as a fixed point temperature controller to provide a stable thermal baseline. To meet the application's requirement, however, the DAC1218 is driven by a slow digitally-coded triangle waveform. The DAC's output is fed to A2, whose output drives the 2 M Ω summing resistor. This causes the controller setpoint to vary slowly and predictably through the desired temperature excursion. This characteristic is observable on a strip-chart recording of the oven's temperature (*Figure 6*) over many hours.

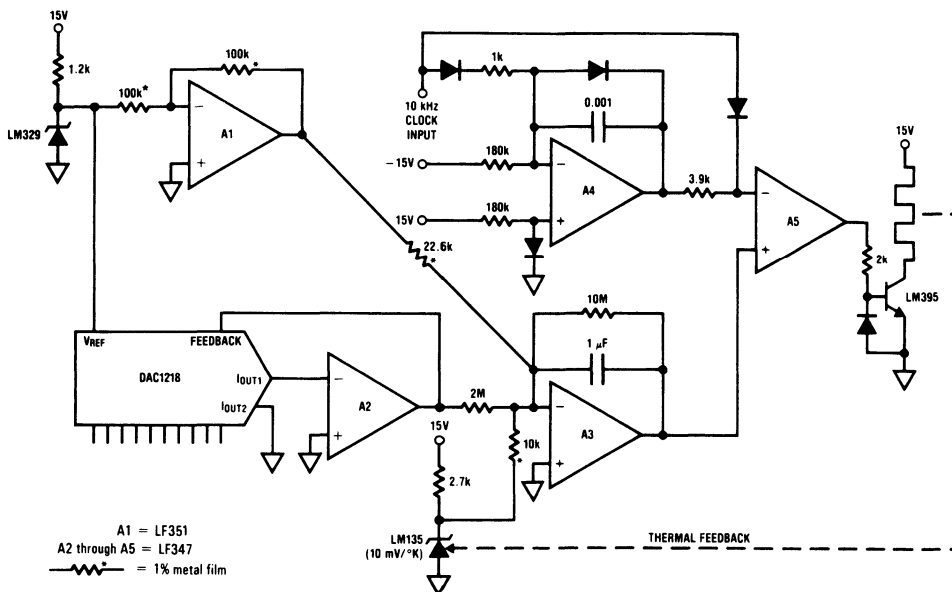


FIGURE 5

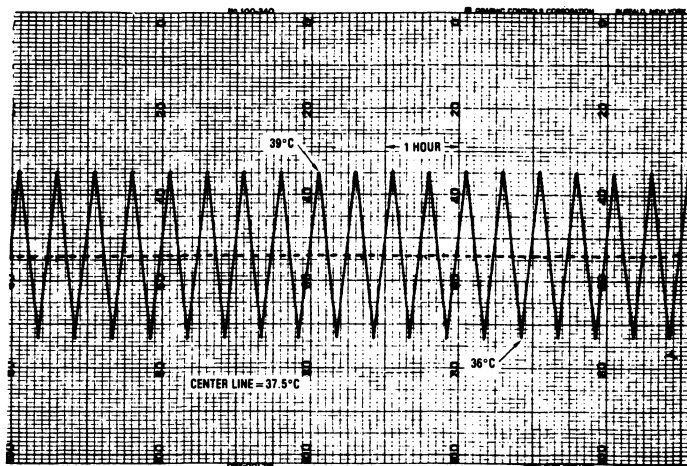


FIGURE 6

TL/H/5636-5

PROCESSOR CONTROLLED SHAKER-TABLE DRIVE

Shaker-tables are frequently employed to test finished assemblies for vibration induced failures under various conditions of frequency and amplitude. It is often desired to simulate vibration patterns which can greatly vary with duration, frequency and amplitude. In addition, it is useful to be able to vary both amplitude and frequency with precise control over wide dynamic ranges so that narrow resonances in the assembly under test may be observed. The circuit of Figure 7 provides these capabilities. The DAC1218 is used to drive the LF351 integrator. The LF351's output ramps until the current through the 10k resistor just balances the current through the 20k resistor at pin 3 of the LM319 comparator. At this point the comparator changes state, forcing the zener

diode bridge and associated series diode to put an equal but opposite polarity reference voltage. This potential is used as the DAC's reference input as well as the feedback signal to the LM319 "+" input. In this fashion, the integrator output forms a triangle waveform whose output is centered around ground. The DAC input coding controls the frequency, which may vary from 1 Hz to 30 kHz. Calibration is accomplished with the "frequency trim" potentiometer. The triangle waveform is shaped by the 2N3810-LM394 configuration which relies on the logarithmic relationship between V_{BE} and collector current in the LM394 to smooth the triangle into a sine wave. The two potentiometers associated with the

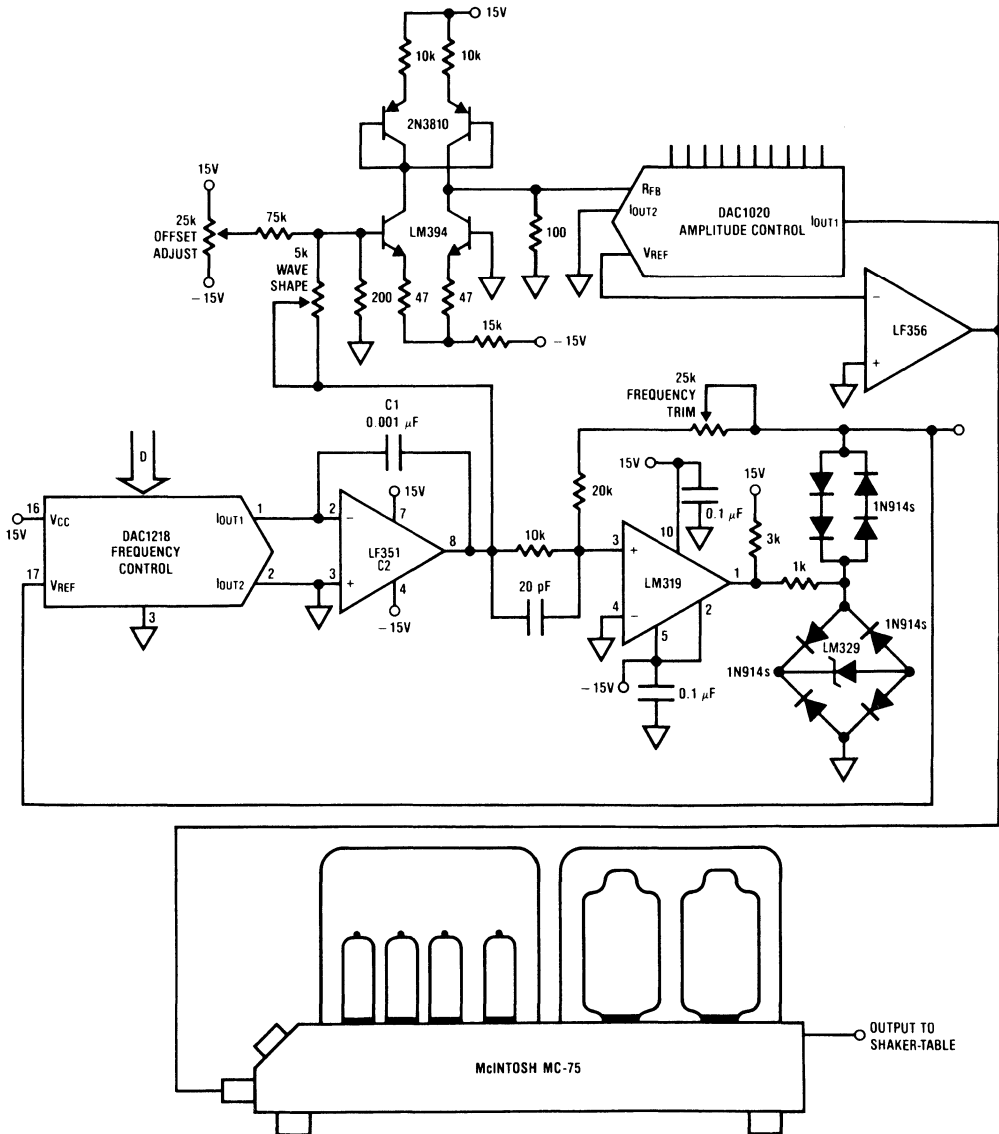
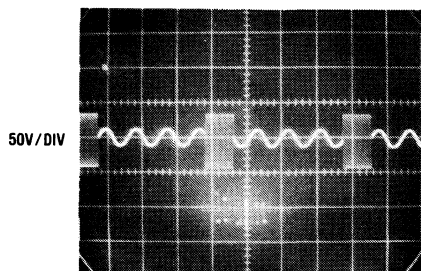


FIGURE 7

TL/H/5636-6

shaper are adjusted for minimum indicated distortion on a distortion analyzer. The DAC1020 and the LF356 are arranged in a DAC-controlled gain configuration which allows the amplitude of the sine wave to be varied over a range from millivolts to volts at the LF356 output. The low input impedance and high inductance of a typical shaker-table presents a difficult load for a solid state amplifier to drive, and vacuum tube amplifiers are frequently employed to avoid

output stage failures. In this example, the amplifier specified is a well-known favorite for the job because its transformer-isolated input is immune to the inductive flyback spikes a shaker-table can generate. *Figure 8* shows the output waveform when both DACs are simultaneously updated. The output waveform changes in frequency and amplitude with essentially instantaneous response.



HORIZONTAL = 2 ms / DIV

TL/H/5636-7

FIGURE 8

Special Sample and Hold Techniques

National Semiconductor
Application Note 294



Although standard devices (e.g., the LF398) fill most sample and hold requirements, situations often arise which call for special capabilities. Extended hold times, rapid acquisition and reduced hold step are areas which require special circuit techniques to achieve good results. The most common requirement is for extended hold time. The circuit of *Figure 1* addresses this issue.

EXTENDED HOLD TIME SAMPLE AND HOLD

In this circuit, extended hold time is achieved by "stacking" two sample and hold circuits in a chain. In addition, rapid acquisition time is retained by use of a feed-forward path. When a sample command is applied to the circuit (trace A, *Figure 2*), A1 acquires the input very rapidly because its

0.002 μF hold capacitor can charge very quickly. The sample command is also used to trigger the DM74C221 one-shot (trace B, *Figure 2*), which turns on the FET switch, S1. In this fashion, A1's output is fed immediately to the A3 output buffer. During the time the one-shot is high, A2 acquires the value of A1's output. When the one-shot drops low, S1 opens, disconnecting A1's output from A3's input. At this point A2's output is allowed to bias A3's input and the circuit output does not change from A1's initial sampled value. Trace C details what happens when S1 opens. A small glitch, due to charge transfer through the FET, appears but the steady state output value does not change. This circuit will acquire a 10V step in 10 μs to 0.01% with a droop rate of just 30 $\mu\text{V}/\text{second}$.

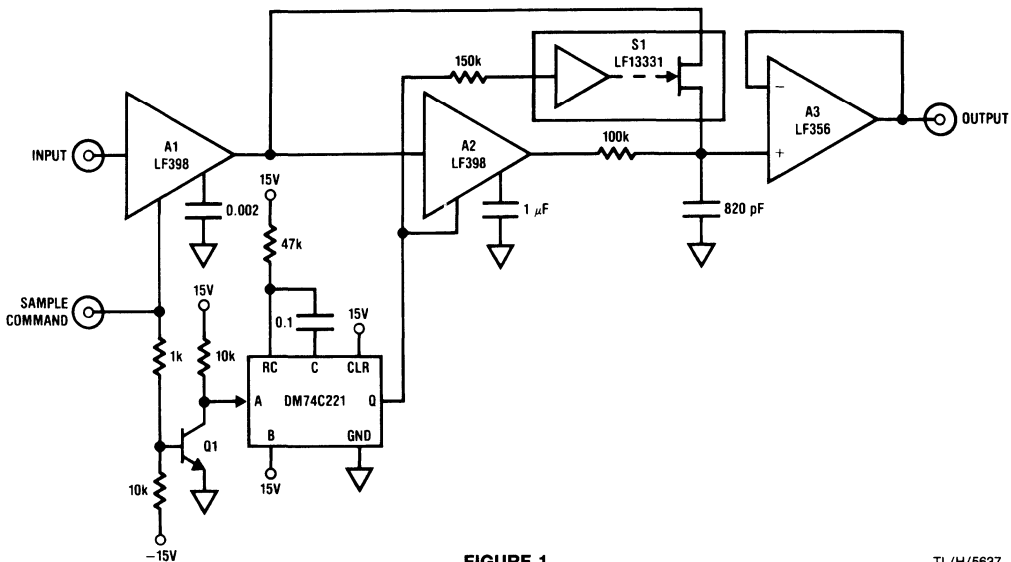
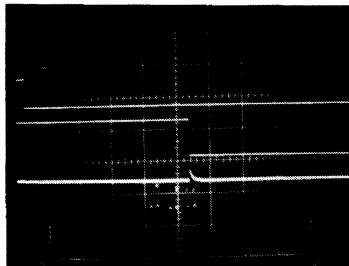


FIGURE 1

TL/H/5637-1

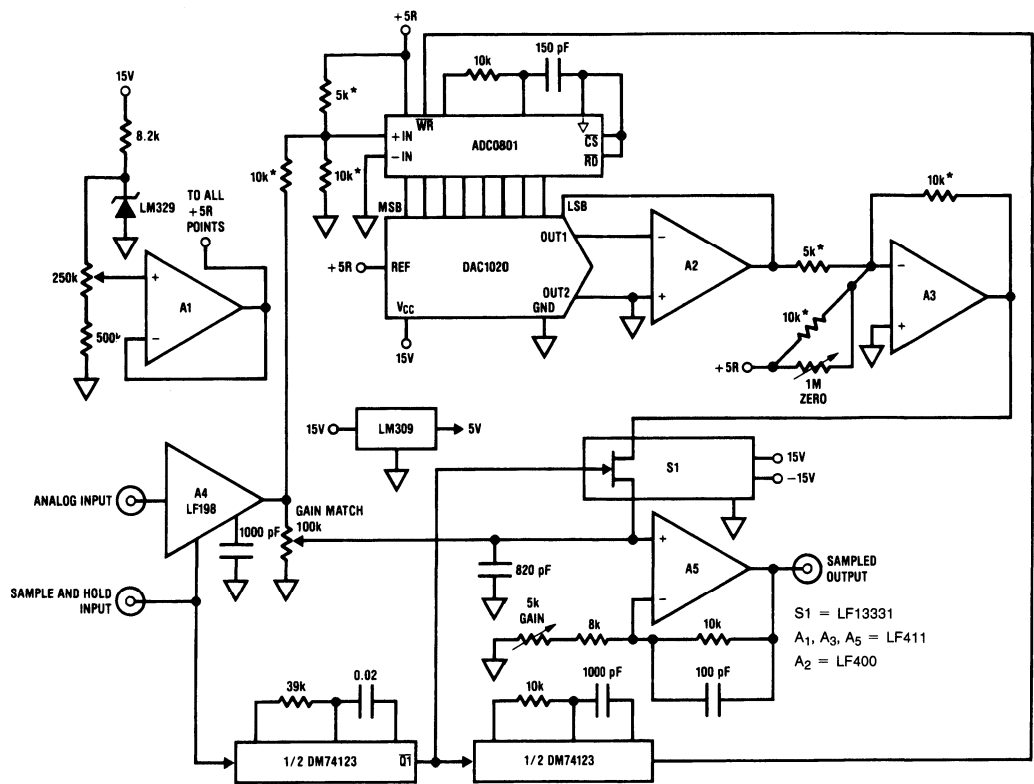
A = 5V/DIV
B = 10V/DIV
C = 50 mV/DIV
(AC COUPLED)



HORIZONTAL = 1 ms/DIV

FIGURE 2

TL/H/5637-2



*Ratio match 0.1%

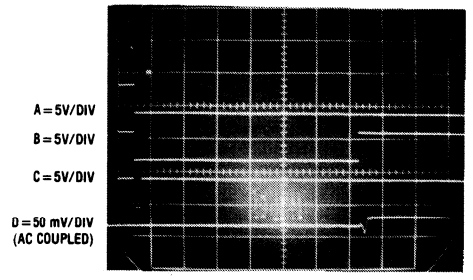
FIGURE 3

TL/H/5637-3

INFINITE HOLD SAMPLE AND HOLD

Figure 3 details a circuit which extends the hold time to infinity with an acquisition time of 10 μ s. Once a signal has been acquired, this circuit will hold its output with no droop for as long as is desired. If this arrangement, A4's divided down output is fed directly to the circuit output via A5 as soon as a sample command (trace A, Figure 4) is applied. The sample command is also used to trigger the DM74123 one-shots. The first one-shot (trace B, Figure 4) is used to bias the FET switch OFF during the time it is low. The second one-shot (trace C, Figure 4) delivers a pulse to the ADC0801 A/D converter which then performs an A/D conversion on A4's output. The DAC1020, in combination with A2 and A3, converts the A/D output back to a voltage. The A/D/A process requires about 100 μ s. When the one-shot (trace B) times out, its output goes high, closing the FET switch. This action effectively connects A3's output to A5 while disconnecting A4's output. In this manner, the circuit output will remain at the DC level that was originally determined by A4's sampling action. Because the sampled value is stored digitally, no droop error can occur. The precision resistors noted in the circuit provide offsetting capability for the unipolar A/D output so that a -10V to +10V input range can be accommodated. To calibrate this circuit, apply 10V to the input and drive the sample command input with a pulse generator. Adjust the gain match potentiometer so that minimum "hop" occurs at the circuit output when S1 closes. Next, ground the input and adjust the zero

potentiometer for 0V output. Finally, apply 10V to the input and adjust the gain trim for a precise 10V circuit output. Once adjusted, this circuit will hold a sampled input to within the 8-bit quantization level of the A/D converter over a full range of +10V to -10V. Trace D, Figure 4 shows the circuit output in great detail. The small glitch is due to parasitic capacitance in the FET switch, while the level shift is caused by quantization in the A/D. An A/D with higher resolution could be used to minimize this effect.



A, B, C HORIZONTAL = 20 μ s/DIV
D HORIZONTAL = 2 μ s/DIV

TL/H/5637-4

FIGURE 4

HIGH SPEED SAMPLE AND HOLD

Another requirement encountered in sample and hold work is high speed. Although conventional sample and hold circuits can be built for very fast acquisition times, they are difficult and expensive. If the input waveform is repetitive, the circuit of Figure 5 can be employed. In this circuit a very fast comparator and a digital latch are placed in front of a differential integrator. Feedback is used to close a loop around all these elements. Each time an input pulse is applied, the DM7475 latch is opened for 100 ns. If the summing junction error at the LM361 is positive, A1 will pull current out of the junction. If the error is negative, the inverse will occur. After some number of input pulses, A1's output will settle at a DC level which is equivalent to the value of the level sampled during the 100 ns window. Note that the delay time of one-shot A is variable, allowing the sample pulse from one-shot B to be placed at any desired point on the input waveform. Figure 6a shows the circuit waveforms. Trace A is the circuit input. After the variable delay provided by one-shot A, one-shot B generates the

sample pulse (trace B). In this case the delay has been adjusted so that sampling occurs at the mid-point of the input waveform, although any point may be sampled by adjusting the delay appropriately.

Figure 6b shows the circuit at work sampling a 1 MHz sine wave input. The optional comparator (C2) shown in dashed lines is used to convert the sine wave input into a TTL compatible signal for the DM74123 one-shot. Trace A is the sine wave input while trace B represents the output of C2. Trace C is the delay generated by one-shot A and trace D is the sample width window out of one-shot B. Note that this pulse can be positioned at any point on the high speed sine wave with the resultant voltage level appearing at A1's output.

REDUCED HOLD STEP SAMPLE AND HOLD

Another area where special techniques may offer improvement is minimization of hold step. When a standard sample and hold switches from sample to hold, a large amplitude high speed spike may occur. This is called hold step and is usually due to capacitive feedthrough in the FET switches

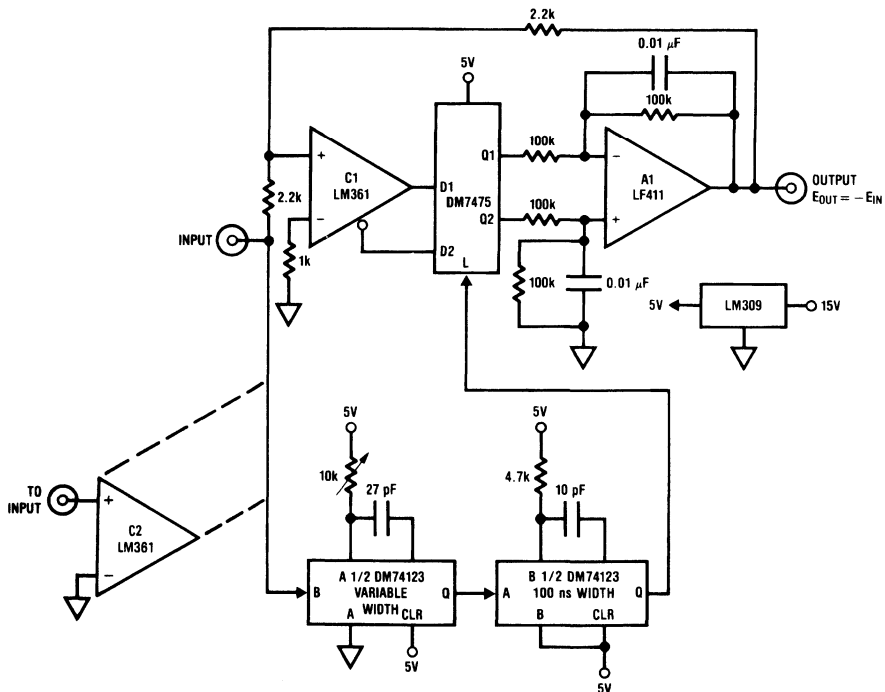


FIGURE 5

TL/H/5637-5

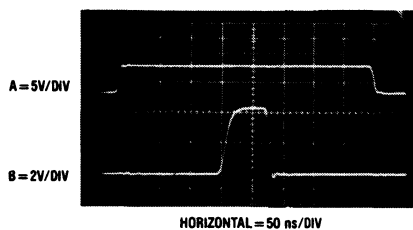


FIGURE 6a

TL/H/5637-6

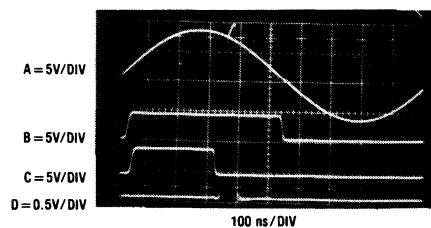


FIGURE 6b

TL/H/5637-7

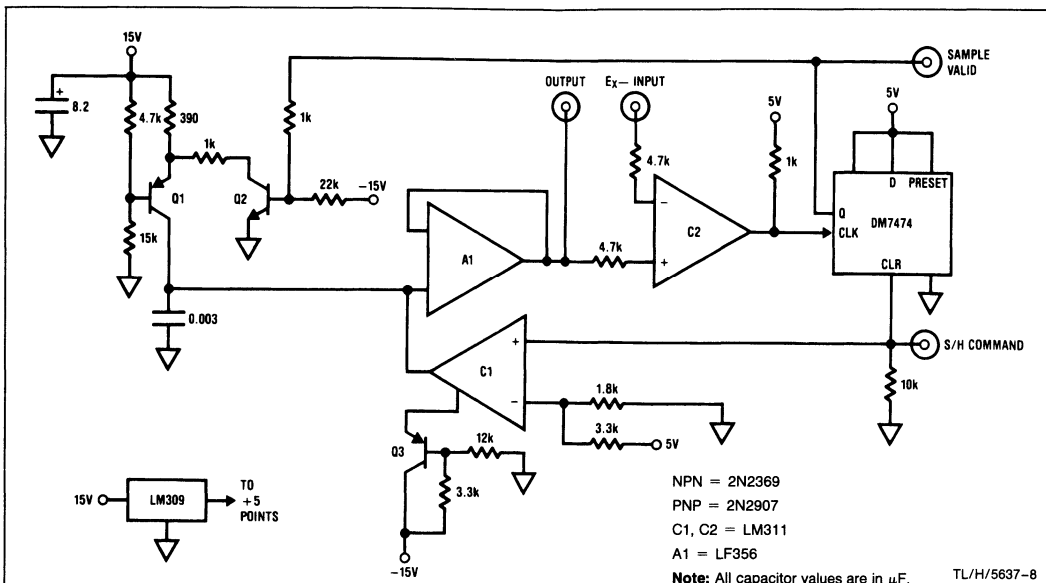


FIGURE 7

used in the circuit. The circuit of Figure 7 greatly reduces hold step by using an unusual approach to the sample and hold function. In this circuit sampling is started when the sample and hold command input goes low (trace A, Figure 8). This action also sets the DM7474 flip-flop low (trace B, Figure 8). At the same time, C1's output clamps at Q3's emitter potential of -12V (trace C, Figure 8). When the sample pulse returns high, C1's output floats high and the $0.003\ \mu\text{F}$ capacitor is linearly charged by current source Q1. This ramp is followed by A1, which feeds C2. When the ramp potential equals the circuit's input voltage, C2's output (trace D, Figure 8) goes high, setting the flip-flop high. This turns on Q2, very quickly cutting off the Q1 current source. This causes the ramp to stop and sit at the same potential at the circuit's input. The hold step generated when the circuit goes into hold mode (e.g., when the flip-flop output goes high) is quite small. Trace E, a greatly enlarged version of trace C, details this. Note the hold step is less than $10\ \text{mV}$ high and only $30\ \text{ns}$ in duration. Acquisition time for this circuit is directly dependent on the input value, at a rate of $5\ \mu\text{s}/\text{V}$.

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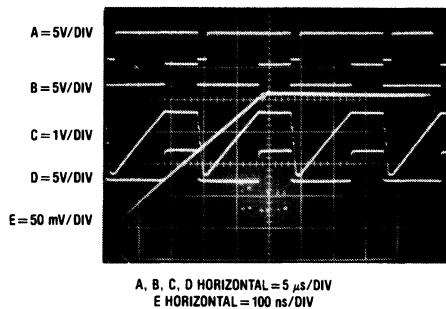


FIGURE 8

TL/H/5637-9

A High Performance Industrial Weighing System

National Semiconductor
Application Note 295

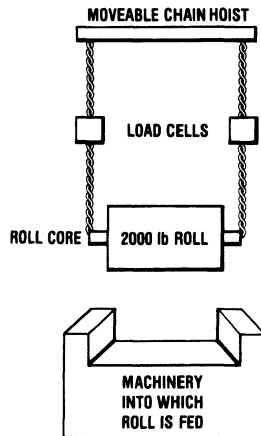


The continuing emphasis on efficiency and waste control in the industrial environment has opened new applications areas for electronic measurement and control systems. Standard electronic techniques can be used to solve many of these application problems. In some areas, however, the measurement requirements are so demanding that novel and unusual circuit architectures must be employed to achieve the desired result. In particular, very high precision transducer-based measurements can be achieved by combining microprocessor and analog techniques. The performance achievable can surpass the best levels obtainable with conventional approaches.

An example of a requirement involves high resolution weighing of 2000 pound rolls of plastic material. In this application, the rolls must be weighed before they are fed into machinery which utilizes the plastic in a coating process. Because the plastic material is relatively expensive, and the number of rolls used over time quite large, it is desirable to keep close tabs on the amount of material actually used in production. This involves weighing the roll before it is used and then weighing the amount of material left on the roll core after it has unwound. In this fashion, the losses accumulated over hundreds of rolls can be tracked and appropriate action taken if the losses are unacceptable. *Figure 1*

shows the way the rolls are handled and fed into the coating machinery. The desired weighing system performance specifications also appear in the figure. *Figure 2* shows the specifications for a typical high quality strain gauge load cell transducer. From this information, it can be seen that the electronic error budget is vanishingly small. The 3 mV/V specification on the load cell means that only 30 mV of full-scale is available for a typical 10V transducer excitation. The desired 0.01% resolution means that only 3 μ V referred-to-input error is allowable. In addition, the gain slope tolerance and temperature coefficients of the load cells, while small, seem to preclude meeting the required specifications. The 0.1% gain slope tolerance also appears to mandate the need for manual system recalibration whenever load cells must be replaced in the field. Finally, assuming these specifications can be met, an A/D converter which will hold near 15-bit stability over the required temperature range is required.

The key to achieving the desired performance is in the realization that the system must be designed as an *integrated* function instead of a group of interconnected signal conditioning blocks. Traditional approaches which rely on "brute force" high stability amplifiers and data converters cannot be successfully used to meet the required specifications.



TL/H/5638-1

FIGURE 1

Desired System Specifications

Accuracy, 0.03%
Stable Resolution, 0.01%
Operating Temperature Range, 10°C to 45°C
Full Load Cell Field Interchangeability
20,000 Count Display

FIGURE 2

Typical Load Cell Specifications

Gain Slope—3 mV/V Excitation $\pm 0.1\%$
Recommended Excitation—10V
Gain Tempco— $\pm 0.0008\%/^{\circ}\text{F}$
Zero Tempco— $\pm 0.0015/^{\circ}\text{F}$

The approach utilized is diagrammed in *Figure 3*. In this arrangement a microprocessor is used to effectively close an analog loop around the load cells with an instrumentation amplifier and an A/D converter. In this system, four discrete measurements are continuously performed on each load cell to determine its error corrected output. Corrections are made for zero and gain drift and a first-order temperature error correction is also made. The actual load cell output voltage is read to complete the measurement cycle. The start of a measurement cycle is initiated by the microprocessor commanding the LF13509 differential input multiplexer A to position 1 (See *Figure 4*). In this position, the amplifier inputs are connected to one side of the transducer bridge. This determines the electrical zero in the system at the common-mode output voltage of the bridge. Physical zero information (e.g., "tare weight") is fed to the microprocessor via a pushbutton which is depressed when no load is in the chain hoist. This operation need only be carried out when the system is first turned on. The multiplexer is then switched to position 2.

In this position, the LM163 inputs are connected across the middle resistor in a string of resistors. The voltage across this resistor represents the precise full-scale output voltage of the load cell transducer. Although the transducers are specified for only 0.1% interchangeability, the precise value of gain slope is furnished with each individual device. This information allows the system to determine the gain slope of the transducer. In practice, the middle resistor in

the string is physically located within the load cell connector. When any such equipped load cell is plugged into the system, the value of this resistor allows immediate and precise gain slope compensation and eliminates the usual manual calibration requirements. When this measurement is completed, the multiplexer is switched to position 3. In this position the output of strain gage bridge A is connected to the LM163 instrumentation amplifier. This signal, which represents the transducer output, is amplified by the LM163, converted by the A/D and stored in memory. The fourth multiplexer operation is used to read the temperature of the load cell. In this position, the output of the LM335 temperature sensor, which is located inside the load cell transducer, is determined and stored in memory. The relatively high level LM335 output is resistively divided by 100 so the LM163 does not saturate. Two separate temperature terms, zero and gain TC, affect the load cell. Although the LM335 provides the absolute cell temperature, the sign of each temperature term in any individual cell will vary. Thus, not only the cell's temperature but the sign for both zero and gain terms must be furnished. This is accomplished by a pin strapping code inside the load cell's connector. This sequence of operations is also performed by multiplexer B for load cell B. When all the information for both transducers has been collected, the microprocessor can determine the actual weight of the roll. The temperature information provides a first-order correction for the relatively small effect of ambient temperature on the load cell's gain and zero terms.

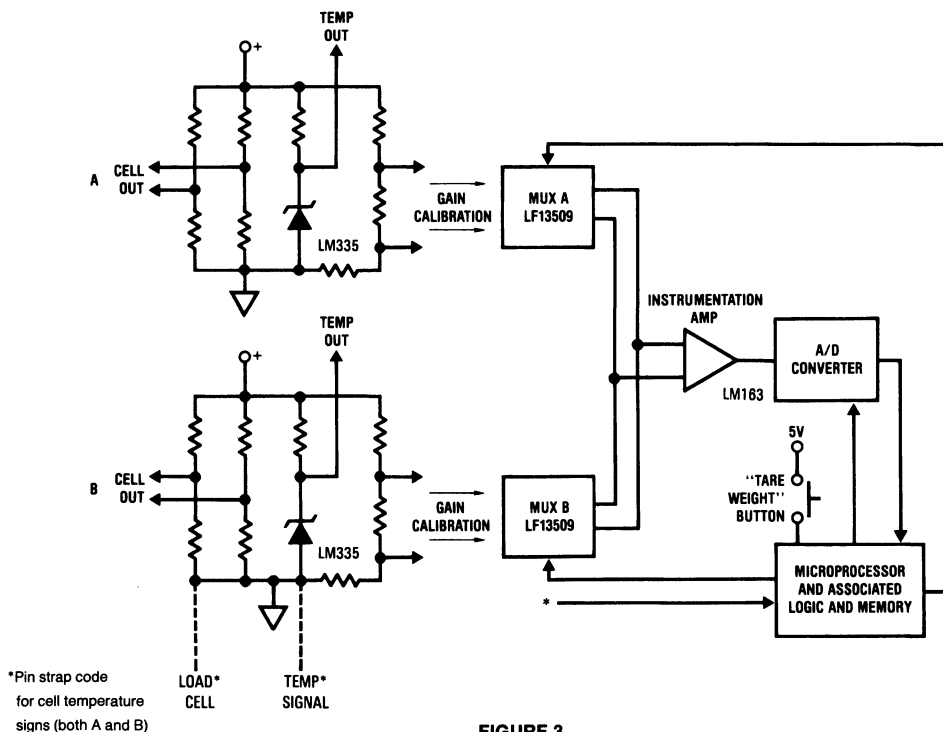


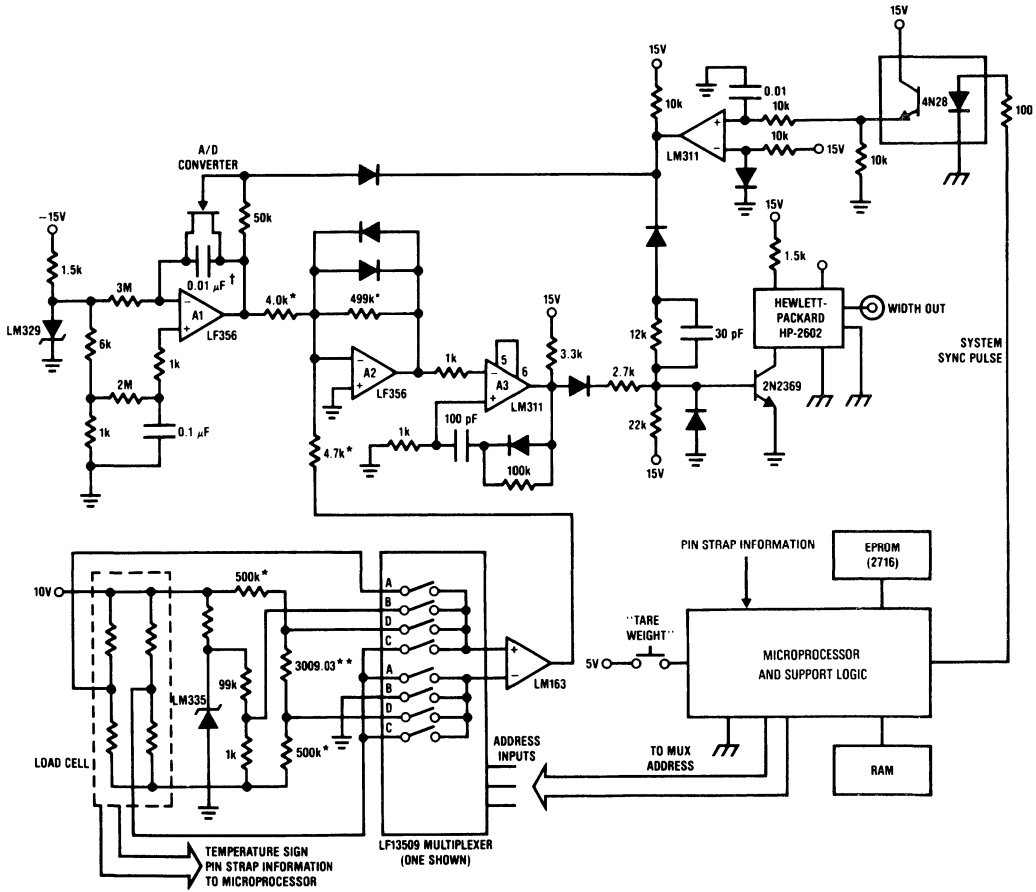
FIGURE 3

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The gain calibration resistor string inside the load cell allows complete field interchangeability with no manual field calibration required. In practice, the load cell connector heads are modified by the addition of the resistor string, temperature sensor and temperature sign pin strapping after the cells have been purchased from the manufacturer. Connector types with the appropriate extra number of pins are substituted for the originals and the completed modified transducer is furnished as a unit to the end user. The stability of this approach is entirely dependent on the resistors in the gain calibration string. The voltage drive to the bridge need not be stable because it is common to the gain calibration string and ratiometrically cancels. Low pass filtering of electrical and mechanical noise is achieved by displaying the digitally-averaged value of a number of measurement cycles. It is worth noting that zero and gain drifts in the instrumentation amplifier and the A/D converter are continuously

compensated for by the closed loop action of the microprocessor. The sole requirement for these components is that they be linear and have noise limits within the required measurement precision. In this manner, the zero and gain drifts of all active electronic components in the system are eliminated, which considerably simplifies the selection and design of these components.

A schematic diagram of the system appears in Figure 4. For purposes of clarity only, one load cell and its associated multiplexer are shown. Details of the microprocessor are also not included. The LF11509 multiplexer feeds the LM163 instrumentation amplifier. The LM163's output is routed to the A/D converter section which is composed of a ramp generator (A1) and a precision comparator circuit (A2-A3). The output of the A/D is a pulse width which varies with the LM163's output amplitude. This pulse width is fed to the microprocessor which uses it to gate a high speed clock. A

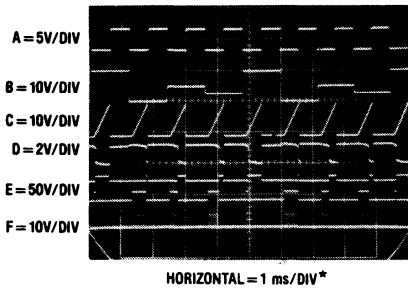


†Teflon
 *Ultronix 104A ratio match 0.005%.
 **Ultronix 104A, 0.01% value shown is ideal for precise 30 mV output load cell and must be selected at load cell test.

FIGURE 4

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loop is completed by using the microprocessor to control the LF11509 multiplexer address inputs. Operation of the system is best understood by referring to *Figure 5*. Trace A is a system synchronizing pulse which is generated by the microprocessor. Trace B is the output of the LM163, which is connected to the multiplexer. Each time the synchronizing pulse goes low, the multiplexer advances one state. The leftmost multiplexer state in the photograph is the zero signal. The next state is the gain calibration, which is followed by the strain gage bridge output and then the temperature signal. The next 4 multiplexer states repeat this pattern for the other load cell. Each time the multiplexer changes state, the LM163 output is compared to the A1 ramp generator output (trace C) by the A2-A3 comparator. A2 acts as a pre-amplifier for the A3 comparator, insuring a low noise trip point. When the ramp is very close to balancing the current being pulled out of A2's summing junction by the LM163, A2 comes out of diode bound (trace D, *Figure 5*) and trips A3. The rapid slewing, high level signal from A2 allows A3 to have a noise free transition (trace E, *Figure 5*). This output is



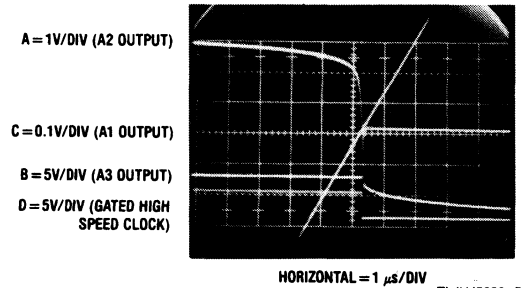
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*System operation normally occurs at a 2 Hz rate but has been sped up for photographic convenience.

FIGURE 5

used to turn off a high speed clock (trace F, *Figure 5*) which was started at the beginning of the ramp (comparator-ramp-high speed clock detail shown in *Figure 6*). The waveforms show that the number of high speed pulses which occur at each multiplexer state varies with the LM163's output. Because the ramp is highly linear and the comparator very stable, a direct relationship between the number of high speed pulses and the LM163 output is assured. The final computed answer at which the microprocessor controlled loop arrives will nullify the effects of drift in the A/D converter and instrumentation amplifier.

In practice, this system has met specifications in the industrial environment for which it was designed. It furnishes a good example of the type of intelligence which is becoming typical in industrial measurement and control apparatus. The interlocking of analog and digital techniques to solve a difficult measurement problem will become even more common in future applications.



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Details of comparator-ramp-high speed clock interaction:

When A2's output comes out of bound (trace A), the A3 comparator responds with a clean, noise-free transition (trace B), causing the high speed clock burst to cease (trace D). Trace C shows the ramp, greatly expanded. A2-A3 trip point occurs just after the ramp passes center screen.

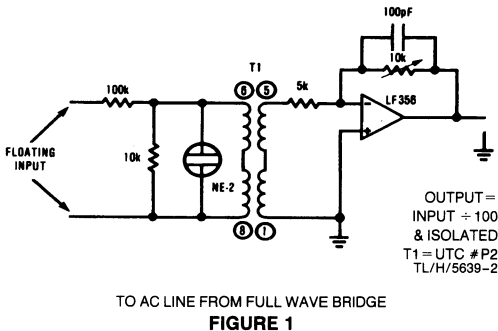
FIGURE 6

Isolation Techniques For Signal Conditioning

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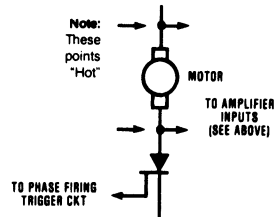


Industrial environments present a formidable challenge to the electronic system designer. In particular, high electrical noise levels and often excessive common mode voltages make safe, precise measurement difficult. One of the best ways to overcome these problems is by the use of isolated measurement techniques. Typically, these approaches utilize transformers or opto isolators to galvanically isolate the input terminals of the signal conditioning amplifier from its output terminal. This breaks the common ground connection and eliminates noise and dangerous common mode voltages. The conflicting requirements for good accuracy and total input/output galvanic isolation requires unusual circuit techniques. A relatively simple isolated signal conditioner appears in *Figure 1*.



FLOATING INPUT HIGH VOLTAGE MOTOR MONITOR

In this inexpensive circuit, a wideband audio transformer permits safe, ground referenced monitoring of a motor which is powered directly from the 115VAC line. *Figure 1A* details the measurement arrangement. The floating amplifier inputs are applied directly across the brush-type motor. The 100k-10k string, in combination with the transformer ratio, provides a nominal 100:1 division in the observed motor voltage while simultaneously allowing a ground referenced output. The NE-2 bulb suppresses line transients while the 10k potentiometer trims the circuit for a precise 100:1 scale factor. To calibrate the circuit, apply a 10-volt RMS 1kHz sine wave to the floating inputs, and adjust the potentiometer for 100 millivolts RMS output. Full power

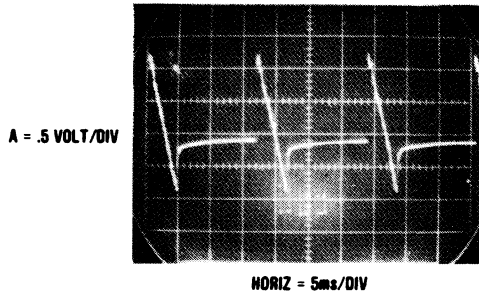


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AC LINE FROM FULL WAVE BRIDGE

FIGURE 1A

bandwidth extends from 15Hz to 45kHz \pm .25dB with the -3dB point beyond 85kHz. Risetime is about 10 microseconds. *Figure 2* shows the motor waveform at the ground referenced circuit output. The isolated, wideband response of the circuit permits safe monitoring of the fast rise SCR turn-on as well as the motor's brush noise.



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FIGURE 2

ISOLATED TEMPERATURE MEASUREMENT

Figure 3 shows a scheme which allows an LM135 temperature sensor to operate in a fully floating fashion. In this circuit, the LM311 puts out a 100 microsecond pulse at about 20Hz. This signal biases the PNP transistor, whose collector load is composed of the 1k Ω unit and the primary of T1. The voltage that develops across T1's primary (waveform A, *Figure 4*) will be directly dependent upon the value that the LM135 temperature sensor clamps the secondary at. Waveform B, *Figure 4* details the transformer primary current.

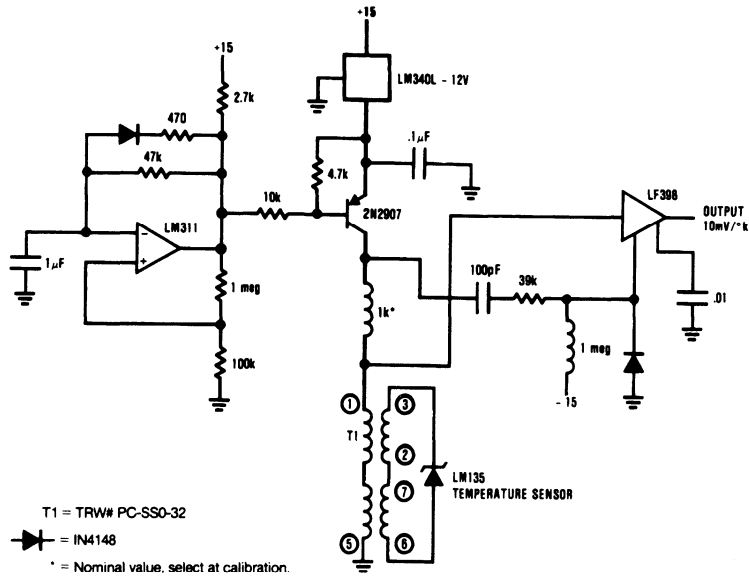


FIGURE 3

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This voltage value, of course, varies with the temperature of the LM135 in accordance with its normal mode of operation. The LF398 sample-and-hold IC is used to sample the transformer primary voltage and presents the circuit output as a DC level. The 100 pF-39k-1M Ω combination presents a trigger pulse (waveform C, *Figure 4*) to the LF398, so that the sampling period does not finish until well after the LM135 has settled. The LM340 12-volt regulator provides power supply rejection for the circuit. To calibrate, replace the LM135 with an LM336 2.5-volt diode of known breakdown potential. Next, select the 1k Ω valve until the circuit output is the same as the LM336 breakdown voltage. Replace the LM336 with the LM135 and the circuit is ready for use.

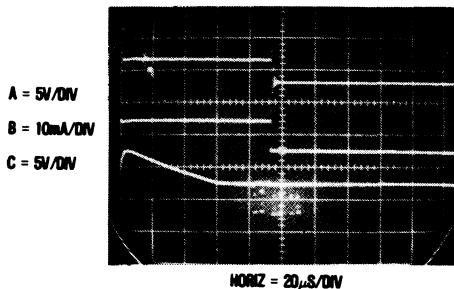


FIGURE 4

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FULLY ISOLATED PRESSURE TRANSDUCER MEASUREMENT

Strain gauge-based transducers present special difficulties if total isolation from ground is required. They need excita-

tion power in addition to their output signal. Some industrial measurement situations require that the transducer must be physically connected to a structure which is floating at a high common mode voltage. This means that the signal conditioning circuitry must supply fully floating drive to the strain gauge bridge, while also providing isolated transducer output signal amplification. *Figure 5* details a way to accomplish this. Here, the strain bridge is excited by a transformer which generates a pulse of servo-controlled amplitude. The pulse is generated by storing the sampled amplitude of the output pulse as a DC level, and supplying this information to a feedback loop which controls the voltage applied to the output switch. A2 functions as an oscillator which simultaneously drives Q2-Q3 and the LF398 (A3) sample mode pin. When A2's output pulse ends, A3's output is a DC level equal to the amplitude of the output pulse which drives the strain bridge. The dual secondary of T1 allows accurate magnetic sampling of the strain bridge output pulse without sacrificing electrical isolation. A3's output is compared to the LH0070 10-volt reference by A4, whose output drives Q1. Q1's emitter provides the DC supply level to the Q2-Q3 switch. This servo action forces the pulses applied to the strain gauge transducer (waveform A, *Figure 6*) to be of constant amplitude and equal to the 10-volt LH0070 reference output. Some amount of the pulse's energy is stored in the 100 μ F capacitor and used to power the LM358 dual (A1) followers. These devices unload the output of the transducer bridge and drive the primary of T2. T2's secondary output amplitude (waveform B, *Figure 6*) represents the transducer output value. This potential is amplified by A5 and fed to A6, a sample-and-hold circuit. A6's sample command is a shortened version of the A2 oscillator pulse. The 74C221 generates this pulse (waveform C, *Figure 6*).

is commanded to reset it to zero volts differential. This basic circuit is not normally considered a very accurate technique, because the dead time, while Q6 is saturated, will cause a large (1%) nonlinearity in the V-to-F transfer curve. However, the addition of R_X causes the reference current flowing through Q2 to include a term which is linearly proportional to the signal, which corrects the transfer nonlinearity.

The NSC MM74C240 inverters are employed because this IC has the only uncommitted inverters with such a low (0.6 to 0.8V) threshold that they can operate on a supply as low as 1.2 volts.

The 49.9k resistors which feed into Q2's emitter act as a gain tempco trim, as Q12's V_{be} is used as a temperature sensor. If the output frequency is 100ppm/C too fast/hot, you can cut the resistor to 20k. If f is too slow/hot, add more resistance in series with the 49.9k. Total current drain for this circuit is about 1 milliamper.

FULLY ISOLATED "ZERO POWER" COMPLETE A/D CONVERTER

Figure 8 shows a complete 8-bit A/D converter, which has all input and output lines fully floating from system ground. In addition, the A/D converter requires *no* power supply for operation! Circuit operation is initiated by applying a convert-command pulse to the "convert-command" input (trace A, Figure 9B). This pulse simultaneously forces the "Data Output" line low (trace B, Figure 9B) and propagates across the isolation transformer. The pulse appears at the transformer secondary (Figure 9A, trace A) and charges the 100 μ F capacitor to five volts. This potential is used to supply power to the floating A/D conversion circuitry. The pulse appearing at the transformer secondary is also used to start the A/D conversion by biasing comparator A's negative input low. This causes comparator A's output to go low, discharging the .06 μ F capacitor (waveform B, Figure 9A). Simultaneously, the 10kHz oscillator (Figure 9A, trace D), formed by

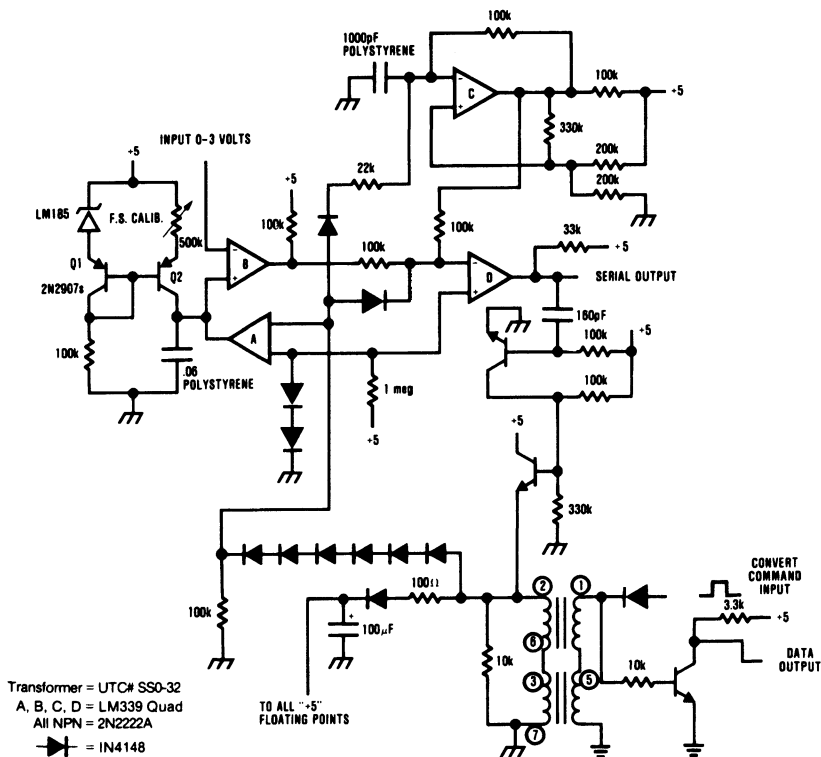


FIGURE 8

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comparator D and its associated components, is forced off via the 22k diode path. A second diode path also forces comparator D's output low (Figure 9A, trace E). Note the cessation of oscillation during the time the convert command pulse is high. When the convert command pulse falls, the Q1-Q2 current source begins to charge the .06 μ F capacitor. During this time, the 10 kHz comparator C oscillator runs, and comparator D's output is a stream of 10 kc clock pulses. When the ramp (trace B, Figure 9A) across the .06 μ F capacitor exceeds the circuit input voltage, comparator B's output goes high (trace C, Figure 9A), forcing comparator D's output low. The number of pulses which appeared at comparator D's output is directly proportional to the value of the circuit's input voltage. These pulses are amplified by the two NPN transistors which are used to modulate the data pulse stream back across the transformer. The six series diodes insure that the modulated data does not appear at comparator A's input and trigger it. The pulses appear at the primary (Figure 9B, trace A) as small amplitude spikes and

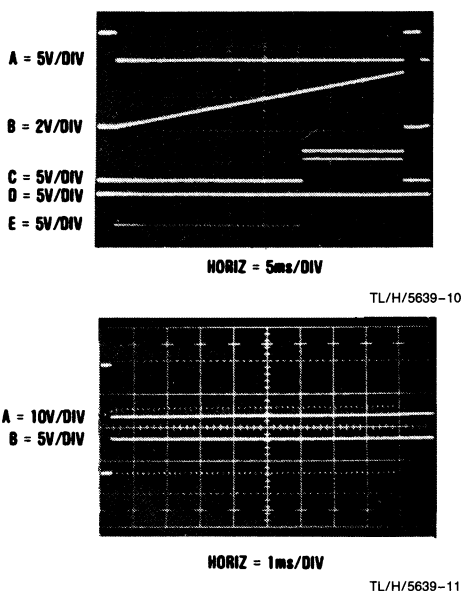


FIGURE 9

are then amplified by the data output transistor, whose collector waveform is trace B or Figure 9B. In this example a 0- to 3-volt input produces 0- to 300 pulses at the output. The 22k diode path averts a +1 count uncertainty error by synchronizing the 10kHz clock to the conversion sequence at the beginning of each conversion. The 500k potentiometer in the current source adjusts the scale factor. The circuit drifts less than 1LSB over $25^{\circ}\text{C} \pm 20^{\circ}\text{C}$ and requires 45 milliseconds to complete a full scale 300 count conversion.

COMPLETE, FLOATING MULTIPLEXED THERMOCOUPLE TEMPERATURE MEASUREMENT

Figure 10 shows a complete, fully floating multiplexed thermocouple measurement system. Power to the floating system is supplied via T2, which runs in a self oscillating DC-DC converter configuration with the 2N2219 transistors. T2's output is rectified, filtered, and regulated to ± 15 volts. An eight channel LF13509 multiplexer is used to sequentially switch 7 inputs and a ground reference into the LM11 amplifier. The LM11 provides gain and cold junction compensation for the thermocouples. The multiplexer is switched from the 74C93 counter, which is serially addressed via the 4N28 opto isolator. The ground referenced channel prevents monitoring instrumentation from losing track of the multiplexer state. The LM11's output is fed into a unity gain isolation amplifier. Oscillator drive for the isolation amplifier is derived by dividing down T2's pulsed output, and shaping the 74C90's output with A4 and its associated components. This scheme also prevents unwanted interaction between the T2 DC-DC converter and the isolation amplifier. This circuit, similar to the servo-controlled amplitude pulser described in Figure 5, puts a pulse across T1's primary. The amplitude of the pulse is directly dependent on the LM11's output value. T1's secondary receives the pulse and feeds into an LF398 sample-and-hold-amplifier. The LF398 is supplied with a delayed trigger pulse, so that T1's output is sampled well after settling occurs. The LF398 output equals the value of the LM11. In this fashion, the fully floating thermocouple information may be connected to grounded test equipment or computers. Effective cold-junction compensation results when the thermocouple leads and the LM335 are held isothermal. To calibrate the circuit, first adjust R3 for an LM11 gain of 245.7. Next, short the "+" input of the LM11 and the LM329 to floating common, and adjust R1 so that the circuit output is 2.982 volts at 25°C . Then, remove the short across the LM329 and adjust R2 for a circuit output of 246 millivolts at 25°C . Finally, remove the short at the LM11 input, and the circuit is ready for use.

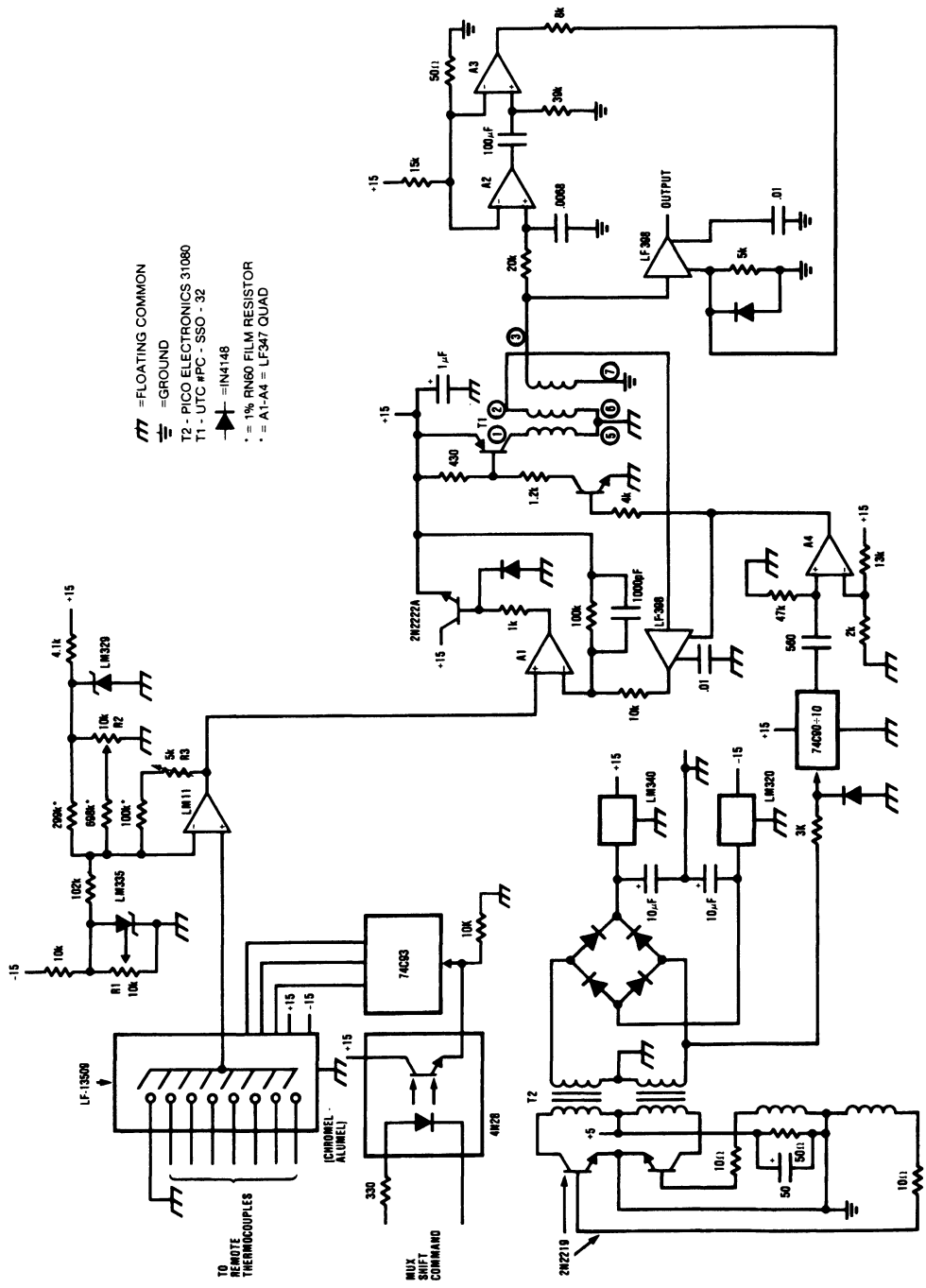


FIGURE 10

Audio Applications of Linear Integrated Circuits

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AN-299

Although operational amplifiers and other linear ICs have been applied as audio amplifiers, relatively little documentation has appeared for other audio applications. In fact, a wide variety of studio and industrial audio areas can be served by existing linear devices. The stringent demands of audio requirements often mean that unusual circuit configurations must be used to satisfy a requirement. By combining off-the-shelf linear devices with thoughtful circuit designs, low cost, high performance solutions are achievable. An example appears in *Figure 1*.

EXPONENTIAL V-F CONVERTER

Studio-type music synthesizers require an exponentially responding V-F converter with a typical scale factor of 1V in per octave of frequency output. Exponential conformity requirements must be within 0.5% from 20 Hz–15 kHz. Almost all existing designs utilize the logarithmic relationship between V_{BE} and collector current in a transistor.

Although this method works well, it requires careful attention to temperature compensation to achieve good results. *Figure 1* shows a circuit which eliminates all temperature compensation requirements. In this circuit, the current into A1's summing junction is exponentially related to the circuit input voltage because of the logarithmic relationship between Q1's V_{BE} and its collector current. A1's output integrates negatively until the Q2-Q5 pair comes on and resets A1 back to 0V. Note that opposing junction tempcos in Q2 and Q5 provide a temperature compensated switching threshold with a small (100 ppm/°C) drift. The -120 ppm/°C drift of the polystyrene integrating capacitor effectively cancels this residual term. In this fashion, A1's output provides the sawtooth frequency output. The LM329 reference stabilizes the Q5-Q2 firing point and also fixes Q1's collector bias. The 3k resistor establishes a 20 Hz output frequency for 0V input, while the 10.5k unit trims the gain to 1V in per octave frequency doubling out. Exponential conformity is within 0.25% from 20 Hz to 15 kHz.

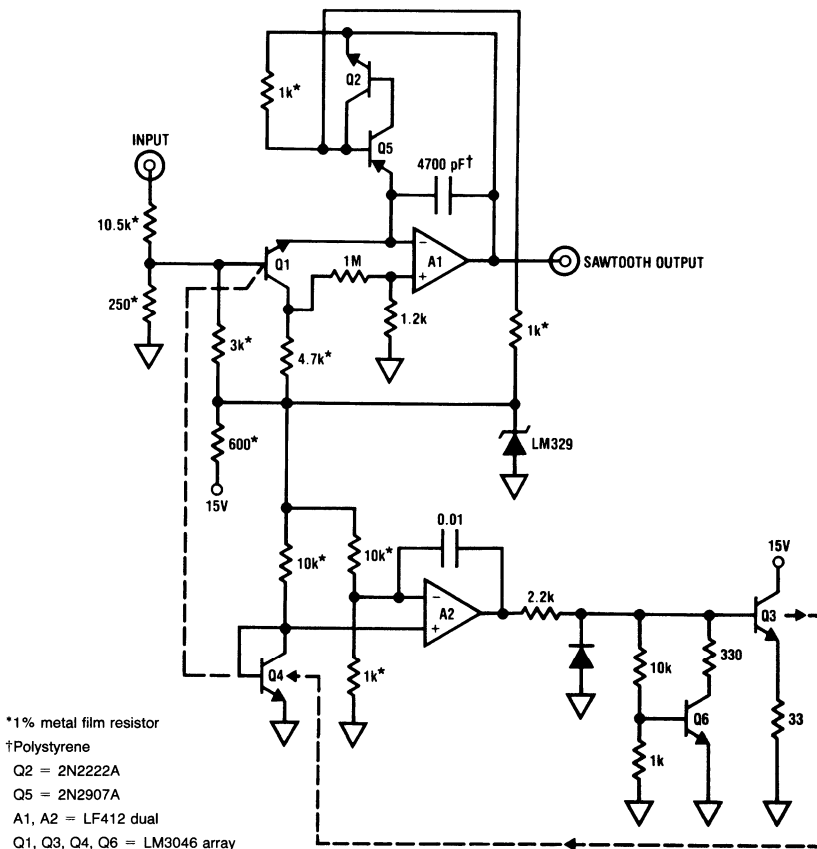


FIGURE 1

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The 1M–1.2k divider at A1's "+" input achieves first order compensation for Q1's bulk emitter resistance, aiding exponential conformity at high frequencies. A2 and its associated components are used to "brute-force" stabilize Q1's operating point. Here, Q3, Q4 and A2 form a temperature-control loop that thermally stabilizes the LM3046 array, of which Q1 is a part. Q4's V_{BE} senses array temperature while Q3 acts as the chip's heater. A2 provides servo gain, forcing Q4's V_{BE} to equal the servo temperature setpoint established by the 10k–1k string. Bias stabilization comes from the LM329. The Q6 clamp and the 33 Ω emitter resistor determine the maximum power Q3 can dissipate and also prevent servo lock-up during circuit start-up. Q1, operating in this tightly controlled environment, is thus immune from effects of ambient temperature shift.

ULTRA-LOW FEEDTHROUGH VOLTAGE-CONTROLLED AMPLIFIER

A common studio requirement is a voltage-controlled gain amplifier. For recording purposes, it is desirable that, when the gain control channel is brought to 0V, the signal input feedthrough be as low as possible. Standard configurations use analog multipliers to achieve the voltage-controlled gain function. In Figure 2, A1–A4, along with Q1–Q3, comprise such a multiplier, which achieves about –65 dB of feedthrough suppression at 10 kHz. In this arrangement, A4 single ends a transconductance type multiplier composed

of A3 along with Q1 and Q2. A1 and A2 provide buffered inputs. The –65 dB feedthrough figure is typical for this type of multiplier. A5 and A6 are used to further reduce this feedthrough figure to –84 dB at 20 kHz by a nulling technique. Here, the circuit's audio input is inverted by A5 and then summed at A6 with the main gain control output, which comes from A4. The RC networks at A5's input provide phase shift and frequency response characteristics which are the same as the main gain control multipliers feedthrough characteristics. The amount of feedthrough compensation is adjusted with the 50k potentiometer. In this way, the feedthrough components (and only the feedthrough components) are nulled out and do not appear at A6's output. From 20 Hz to 20 kHz, feedthrough is less than –80 dB. Distortion is inside 0.05%, with a full power bandwidth of 60 kHz. To adjust this circuit, apply a 20 Vp-p sine wave at the audio input and ground the gain control input. Adjust the 5k coarse feedthrough trim for minimum output at A4. Next, adjust the 50k fine feedthrough trim for minimum output at A6. For best performance, this circuit must be rigidly constructed and enclosed in a fully shielded box with attention given to standard low noise grounding techniques. Figure 3 shows the typical remaining feedthrough at 20 kHz for a 20 Vp-p input. Note that the feedthrough is at least –80 dB down and almost obscured by the circuit noise floor.

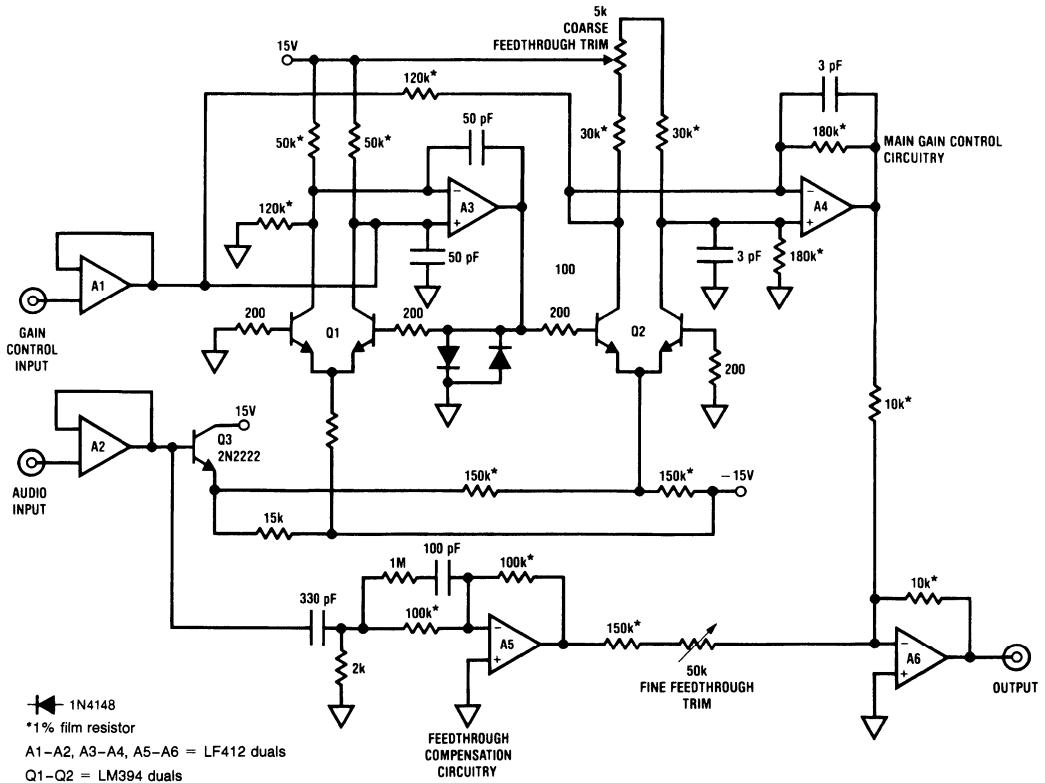
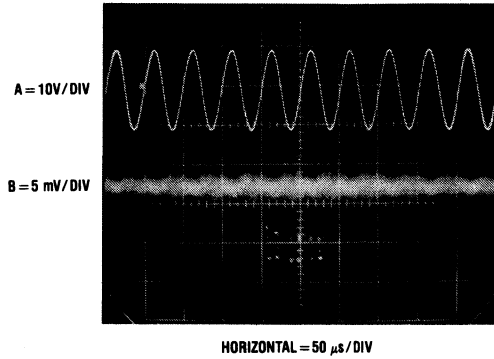


FIGURE 2

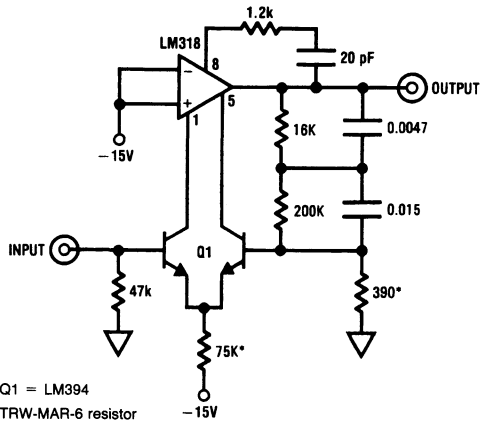
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HORIZONTAL = 50 μ s/DIV

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FIGURE 3



Q1 = LM394

*TRW-MAR-6 resistor

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FIGURE 4

ULTRA-LOW NOISE RIAA PREAMPLIFIER

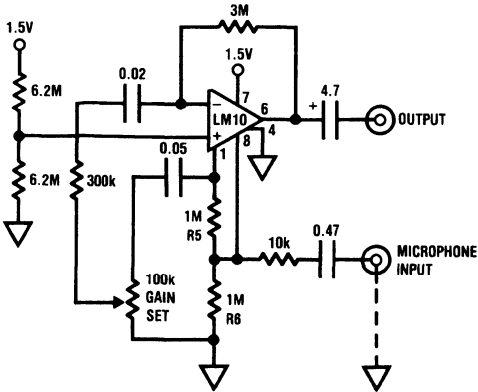
In Figure 4, an LM394 is used to replace the input stage of an LM118 high speed operational amplifier to create an ultra-low distortion, low noise RIAA-equalized phono preamplifier. The internal input stage of the LM118 is shut off by tying the unused input to the negative supply. This allows the LM394 to be used in place of the internal input stage, avoiding the loop stability problems created when extra stages are added. The stability problem is especially critical in an RIAA circuit where 100% feedback is used at high frequencies. Performance of this circuit exceeds the ability of most test equipment to measure it. As shown in the accompanying chart, harmonic distortion is below the measurable 0.002% level over most of the operating frequency and amplitude range. Noise referred to a 10 mV input signal is -90 dB down, measuring 0.55 μ Vrms and 70 pArms in a 20 kHz bandwidth. More importantly, the noise figure is less

Frequency	Total Harmonic Distortion				
	<0.002	<0.002	<0.002	<0.002	<0.002
20	<0.002	<0.002	<0.002	<0.002	<0.002
100	<0.002	<0.002	<0.002	<0.002	<0.002
1000	<0.002	<0.002	<0.002	<0.002	<0.002
10000	<0.002	<0.002	<0.002	<0.0025	<0.003
20000	<0.002	<0.002	<0.004	<0.004	<0.007
Output Amplitude (Vrms)	0.03	0.1	0.3	1.0	5.0

than 2 dB when the amplifier is used with standard phono cartridges, which have an equivalent wideband (20 kHz) noise of 0.7 μ V. Further improvements in amplifier noise characteristics would be of little use because of the noise generated by the cartridge itself. A special test was performed to check for transient intermodulation distortion. 10 kHz and 11 kHz were mixed 1:1 at the input to give an rms output voltage of 2V (input = 200 mV). The resulting 1 kHz intermodulation product measured at the output was 80 μ V. This calculates to 0.0004% distortion, quite a low level, considering that the 1 kHz has 14 dB (5:1) gain with respect to the 10 kHz signal in an RIAA circuit. Of special interest also is the use of all DC coupling. This eliminates the overload recovery problems associated with coupling and bypass capacitors. Worst-case DC output offset voltage is about 1V with a cartridge having 1 k Ω DC resistance.

MICROPHONE PREAMPLIFIER

Figure 5 shows a microphone preamplifier which runs from a single 1.5V cell and can be located right at the microphone. Although the LM10 amplifier-reference combination has relatively slow frequency response, performance can be considerably improved by cascading the amplifier and reference amplifier together to form a single overall audio amplifier. The reference, with a 500 kHz unity-gain bandwidth, is used as a preamplifier with a gain of 100. Its output is fed through a gain control potentiometer to the op amp, which is connected for a gain of 10. The combination gives a 60 dB gain with a 10 kHz bandwidth, unloaded, and 5 kHz, loaded with 500 Ω . Input impedance is 10 k Ω .



TL/H/7496-5

FIGURE 5

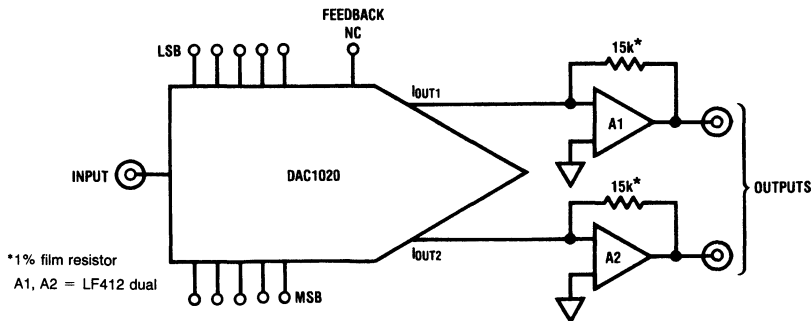
Potentially, using the reference as a preamplifier in this fashion can cause excess noise. However, because the reference voltage is low, the noise contribution which adds root-mean-square, is likewise low. The input noise voltage in this connection is 40 nV – 50 nV/ $\sqrt{\text{Hz}}$, approximately equal to that of the op amp.

One point to observe with this connection is that the signal swing at the reference output is strictly limited. It cannot swing much below 150 mV, nor closer than 800 mV to the supply. Further, the bias current at the reference feedback terminal lowers the output quiescent level and generates an uncertainty in this level. These facts limit the maximum feedback resistance (R5) and require that R6 be used to optimize the quiescent operating voltage on the output. Even so, one must consider the fact that limited swing on the preamplifier can reduce maximum output power with low settings on the gain control.

In this design, no DC current flows in the gain control. This is perhaps an arbitrary rule, designed to insure long life with noise-free operation. If violations of this rule are acceptable, R5 can be used as the gain control with only the bias current for the reference amplifier (<75 nA) flowing through the wiper. This simplifies the circuit and gives more leeway in getting sufficient output swing from the preamplifier.

DIGITALLY PROGRAMMABLE PANNER-ATTENUATOR

Figure 6 shows a simple, effective way to use a multiplying CMOS D-A converter to steer or pan an audio signal between two channels. In this circuit, the current outputs of the DAC1020, which are complementary, each feed a current-to-voltage amplifier. The amplifiers will have complementary voltage outputs, the amplitude of which will depend upon



*1% film resistor
A1, A2 = LF412 dual

TL/H/7496-6

FIGURE 6

the address code to the DAC's digital inputs. *Figure 7* shows the amplifier outputs for a ramp-count code applied to the DAC digital inputs. The 1.5 kHz input appears in complementary amplitude-modulated form at the amplifier outputs. The normal feedback connection to the DAC is not used in this circuit. The use of discrete feedback resistors facilitates gain matching in the output channels, although each amplifier will have a ≈ 300 ppm/ $^{\circ}\text{C}$ gain drift due to mismatch between the internal DAC ladder resistors and the discrete feedback resistors. In almost all cases, this small error is acceptable, although two DACs digitally addressed in complementary fashion could be used to totally eliminate gain error.

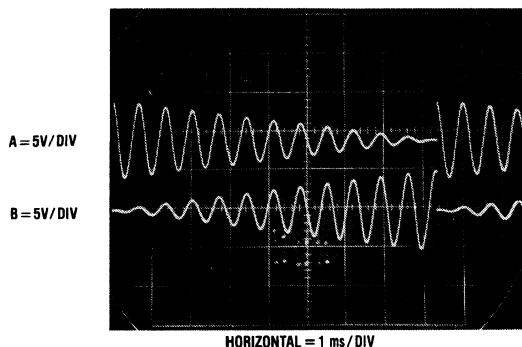
DIGITALLY PROGRAMMABLE BANDPASS FILTER

Figure 8 shows a way to construct a digitally programmable first order bandpass filter. The multiplying DAC's function

is to control cut-off frequency by controlling the gain of the A3–A6 integrators, which has the effect of varying the integrators' capacitors. A1–A3 and their associated DAC1020 form a filter whose high-pass output is taken at A1 and fed to an identical circuit composed of A4–A6 and another DAC. The output of A6 is a low-pass function and the final circuit output. The respective high-pass and low-pass cut-off frequencies are programmed with the DAC's digital inputs. For the component values shown, the audio range is covered.

REFERENCES

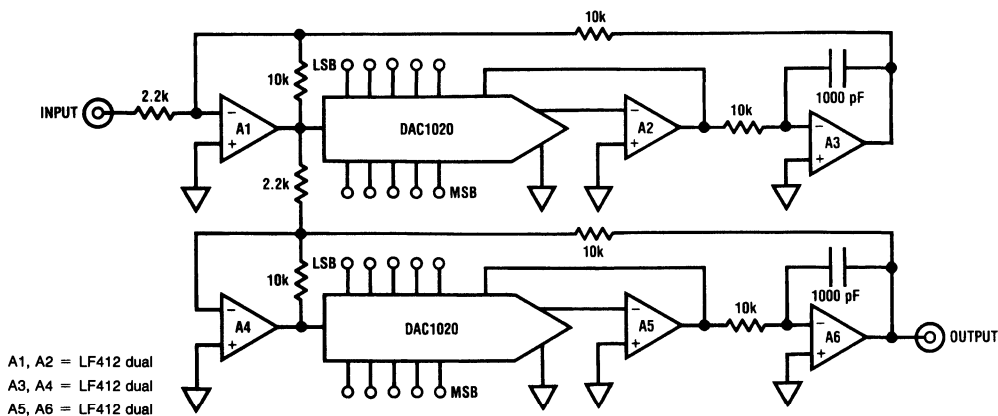
Application Guide to CMOS Multiplying D-A Converters, Analog Devices, Inc. 1978



HORIZONTAL = 1 ms / DIV

TL/H/7496-7

FIGURE 7



A1, A2 = LF412 dual
A3, A4 = LF412 dual
A5, A6 = LF412 dual

TL/H/7496-8

FIGURE 8

Simple Circuit Detects Loss of 4-20 mA Signal

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Application Note 300
Robert A. Pease



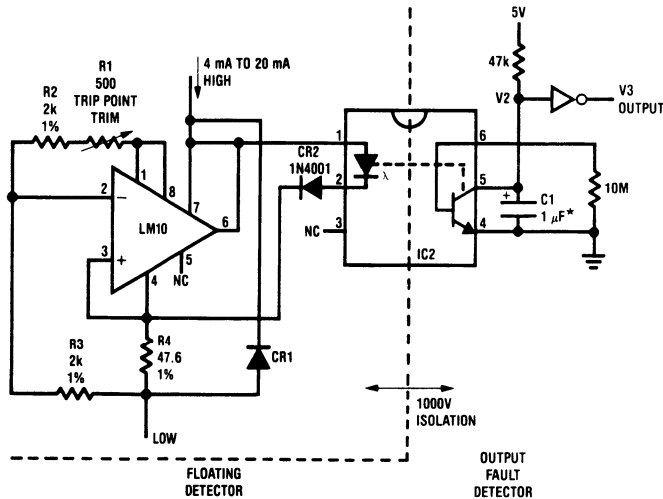
Four-to-twenty milliampere current loops are commonly used in the process control industry. They take advantage of the fact that a remote amplifier can be powered by the same 4-20 mA current that it controls as its output signal, thus using a single pair of wires for signal and power. Circuits for making 4-20 mA transmitters are found in the LM10, LM163, and LH0045 data sheets.

In general, an expensive isolation amplifier would be required to detect the case of a 4 mA signal falling out of spec (e.g., 3.7 mA) without degrading the isolation of the 4-20 mA current loop.

But this new circuit (*Figure 1*) can detect a loss or degradation of signal below 4 mA, with simplicity and low cost. The LM10 contains a stable reference at pins 1 and 8, 200 mV positive referred to pin 4. As long as the loop current is larger than 4 mA, the $I \times R$ drop across the 47.6Ω resistor, R4, is sufficient to pull the LM10's amplifier input (pin 2) below pin 3 and keep its output (pin 6) turned OFF.

The 4-20 mA current will flow through the LED in the optoisolator

and provide a LOW output at pin 5 of the optoisolator. When the current loop falls below 3.7 mA, the LM10's input at pin 2 will rise and cause the pin 6 output to fall and steal all the current away from the LED in the optoisolator. Pin 5 of the 4N28 will rise to signify a *fault* condition. This *fault* flag will fly for any loop current between 3.7 mA and 0.0 mA (and also in case of reversal or open-circuit). R1 is used to trim the threshold point to the desired value. CR2 is added in series with the LED to make sure it will turn OFF when the LM10's output goes LOW. (While the LM10 is guaranteed to saturate to 1.2V, the forward drop of the LED in the 4N28 may be as low as 1.0V, so a diode is added in series with the LED, to insure that it can be shut off.) Note that most operational amplifiers will not respond in a reasonable way if the output pin (6) is connected to the positive supply pin (7), but the LM10 was specifically designed and is specified to perform accurately in this "shunt" mode. (Refer to AN-211 application note, TP-14 technical paper, and the LM10 data sheet.)



CR1 = 1N4001, optional, in case of signal reversal
LM10 = NSC LM10CLN or LM10CLH amp/reference
IC2 = 4N28 or similar, optoisolator

V2 = Normally low; high signifies fault ($I < 3.7$ mA)

V3 = Normally high; low signifies fault ($I < 3.7$ mA) (buffered output)

*C1 = 1 μF optional, to avoid false output when large AC current is superimposed on 4.0 mA. Disconnect this capacitor when using with circuit of *Figure 2*.

◻ = 1/8 MM74C04 or similar, CMOS inverter

FIGURE 1. Current Loop Fault Detector

TL/H/5640-1

While you could manually adjust R1 while observing the status of V3 output, this would be a coarse and awkward trim procedure. *Figure 2* shows an improved test circuit which serves the current through the detector circuit, forcing it to be at the threshold value. Then that current can be monitored continuously, and the circuit can be trimmed easily. If the current through R107 starts out too small, the output of the 4N28 will be *HIGH* too much of the time, and the op amp output will integrate upwards until the current is at the actual threshold of the detector. The integrator's output will stop at the value where the duty cycle of the 4N28 out-

put is exactly 50%. This occurs when the current through R107 is straddling the threshold value.

The positive feedback via R108 assures that the loop oscillates at approximately 50 cycles per second, with a small, well-controlled sawtooth wave at its output. This mode of operation was chosen to insure that the loop does not oscillate at some high, uncontrolled frequency, as it would be difficult in that case to be sure the duty cycle was exactly 50%. This test circuit is advantageous, because you can measure the trip point directly.

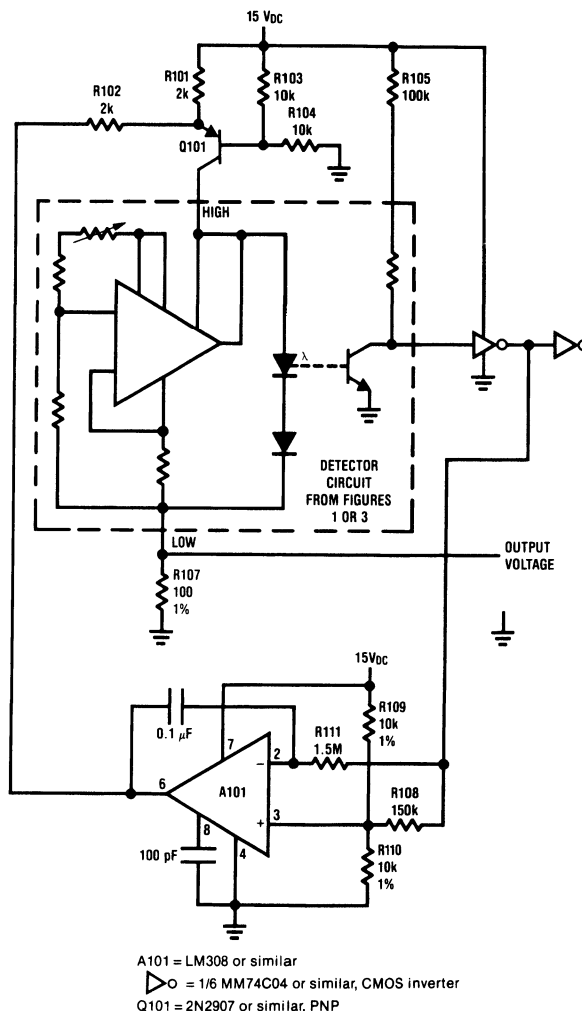


FIGURE 2. Test Circuit for Threshold Detector

TL/H/5640-2

The test circuit of *Figure 2* is necessary for trimming the detector in *Figure 3*. This circuit does not have a trim pot, and thus avoids the problem of someone mis-adjusting the circuit after it is once trimmed correctly. It also avoids the compromises between good but expensive trim pots and cheap but unreliable, drifty trim pots. By opening one or more of the links, L1–L4, according to the following procedure, it is easy to trim the threshold level to be within 1% of 3.70 mA (or as desired).

- Observe the DC current through R107 in *Figure 2*
- If $I_{THRESHOLD}$ is larger than 3.950 mA, open link L1; —if not, don't
- If $I_{THRESHOLD}$ is larger than 3.830 mA, open link L2; —if not, don't

- If $I_{THRESHOLD}$ is larger than 3.760 mA, open link L3; —if not, don't
- Then, if $I_{THRESHOLD}$ is larger than 3.720 mA, open link L4; —if not, don't

This procedure provides a circuit trimmed to much better than 1% of 3.70 mA, without using any trim pots. Of course, this circuit can be used to detect drop-out of regulation of other floating signals, while maintaining high isolation from ground, good accuracy, low power dissipation ($2\text{ mA} \times 2.5\text{ V}$ typical) and low cost.

Other standard values of current loop are 1 mA–5 mA and 10 mA–50 mA. The version shown in *Figure 4* uses higher resistance values to trip at 0.85 mA. The circuit in *Figure 5* has an additional transistor, to accommodate currents as large as 50 mA without damage or loss of accuracy, and provide an 8.5 mA threshold.

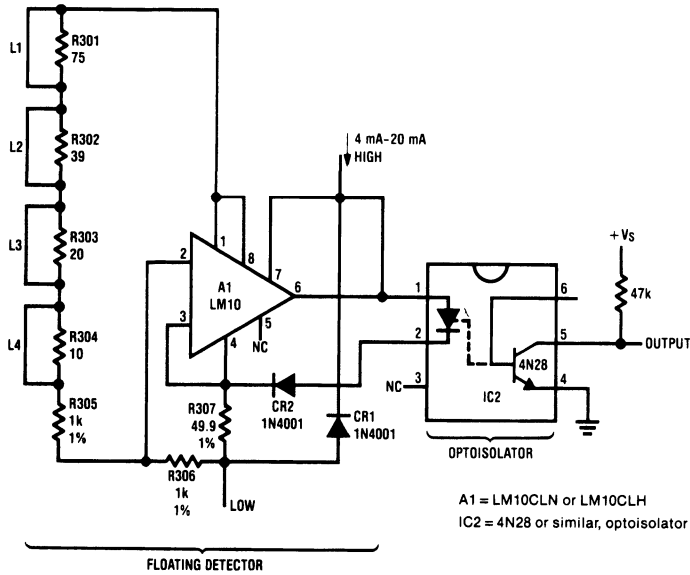


FIGURE 3. Fault Detector with Low-Cost Trim Scheme
(To be trimmed in the circuit of *Figure 2*)

TL/H/5640-3

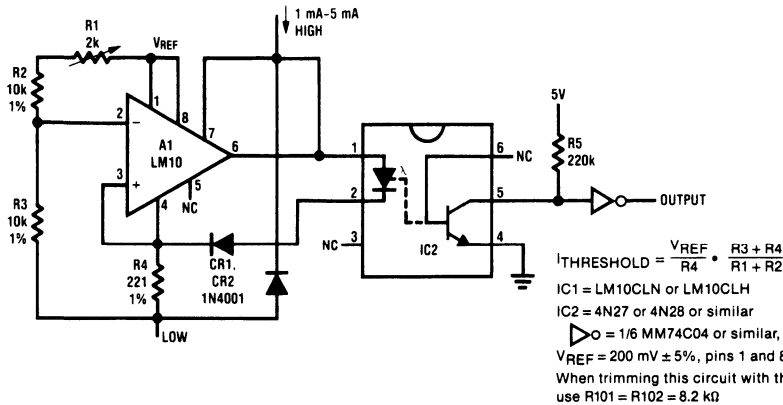
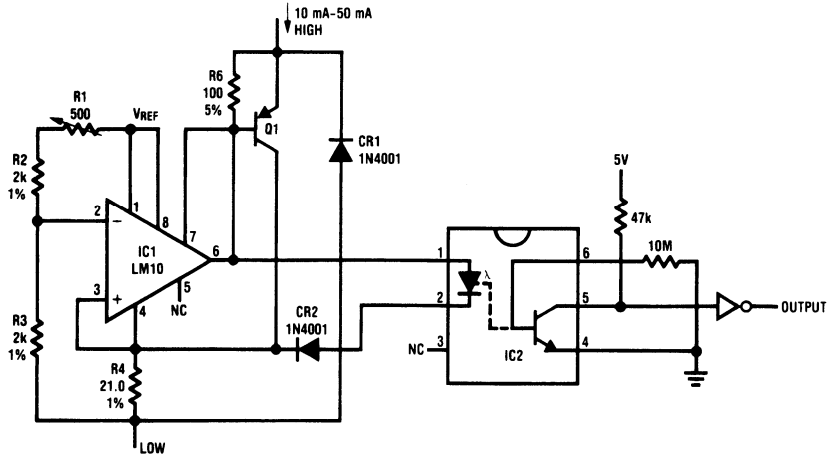


FIGURE 4. Current Loop Fault Detector
($I_{THRESHOLD} = 0.85\text{ mA}$ for 1 mA–5 mA Current Loops)

TL/H/5640-4



$$-I_{\text{THRESHOLD}} = \frac{V_{\text{REF}}}{R_4} \cdot \frac{R_3 + R_4}{R_1 + R_2}$$

IC1 = LM10CLH or LM10CLN op amp and reference

$V_{\text{REF}} = 200 \text{ mV} \pm 5\%$, pins 1 and 8 referred to pin 4

IC2 = 4N28 or similar, optoisolator

\triangle = 1/6 MM74C04 or similar, CMOS inverter

Q1 = 2N2904 or 2N2907, any silicon PNP

When trimming this circuit with the circuit of *Figure 2*, use $R_{101} = R_{102} = 820\Omega$

TL/H/5640-5

FIGURE 5. Current Loop Fault Detector
($I_{\text{THRESHOLD}} = 8.5 \text{ mA}$, for 10 mA-50 mA Current Loops)

Signal Conditioning for Sophisticated Transducers

A substantial amount of information is available on signal conditioning for common transducers. Fortunately, most of these devices, which are used to sense common physical parameters, are relatively easy to signal condition. Further, most transducer-based measurement requirements are well served by standard transducers and signal conditioning techniques.

Some situations, however, require sophisticated transduction techniques with their attendant special signal conditioning requirements. This application note details signal conditioning and applications information for a diverse group of sophisticated and unusual transducers. Because these devices are unusual or somewhat difficult to signal condition, relatively little material has appeared on how to design circuitry for them. Many of these devices permit measurements which cannot be accomplished in any other way. For this reason it is worthwhile to have a basic familiarity with

National Semiconductor
Application Note 301



their capabilities and what is required to signal condition them. The circuits shown are intended as instructive examples only, although each one has been constructed and tested. Every individual transducer application has a set of specifications and constraints which will require modification or revision of the circuits presented. Sources of additional information which feature more vigorous treatment are presented in a reference section at the end of the application note.

PHOTOMULTIPLIER TUBE (PMT)

Perhaps the most versatile light detector available is the photomultiplier tube (PMT). These sensors allow single photon detection, sub-nanosecond rise time, bandwidths approaching 1 GHz and linearity of response over a range of 10^7 . In addition, they feature extremely low noise, stable characteristics and very long life. *Figure 1a* details a typical

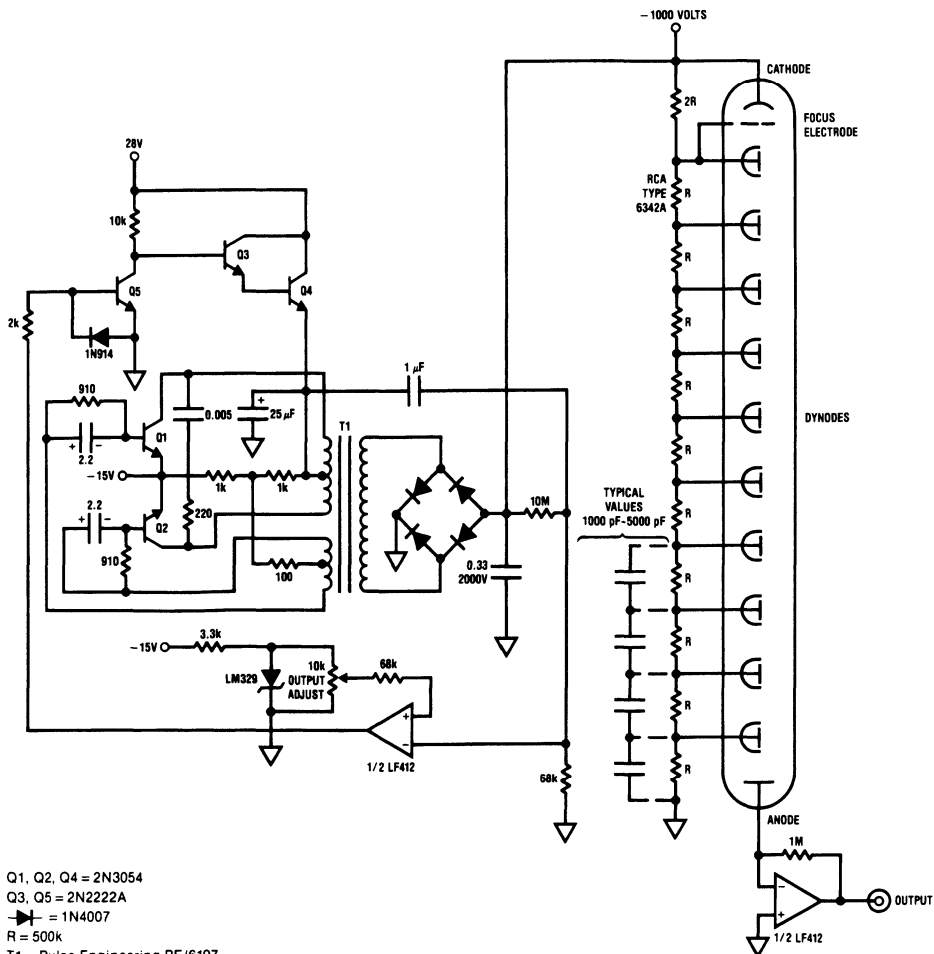


FIGURE 1a

TL/H/5641-1

PMT along with a signal conditioning circuit. The tube is composed of a photosensitive cathode, an anode, a focusing electrode and ten dynode stages. In operation, the photocathode, which is high voltage biased with respect to the dynodes, emits photoelectrons when it is struck by light. These are focused into a beam and directed to the first dynode stage by the focus electrode. These arriving electrons impinge on the dynode, causing secondary emission to occur. As a result, a greater number of electrons leave the dynode and are then directed to the second dynode. In this fashion, a number (e.g., 10) of dynode stages are used to achieve overall gains of 10^6 to 10^8 . The electrons from the final dynode are collected by the anode, which provides the output current of the tube. In contrast to other vacuum tubes, the PMT does not use a filament to thermionically generate electrons. Instead, the photocathode, in combination with incident light, initiates the electrons. The absence of a filament means there are no degradation, heat or out-gassing problems and the life of a PMT is very long.

Signal conditioning involves generating a stable high voltage supply and accomplishing a low noise current-to-voltage conversion at the anode. In this example, a DC-DC converter is used to supply the dynode potentials to the tube. The supply is stabilized by the LF412 amplifier which drives the Q3-Q5 combination to complete a feedback loop around the Q1-Q2 driven transformer. The LM329 provides a stable servo reference. In general, the regulation of a PMT supply should be at least ten times greater than the required measurement gain stability because of the relationship between a PMT's gain slope and the high voltage applied. The cathode and dynodes are biased from the high voltage supply via divider resistors. The resistors distribute the dynode potentials in proportion to a ratio which is specified for each tube type. To prevent non-linear response, the current through the divider string should be at least ten times the maximum expected current out of the tube. Some high speed pulse applications can generate transient high tube currents which may require the small capacitors shown in dashed lines. The anode is the tube output and appears as an almost ideal current source. The LF412 amplifier performs a current-to-voltage conversion with the 1 M Ω resistor setting the output scale factor.

The PMT's combination of high speed and extreme sensitivity suits it to a variety of difficult light measurement chores. The remarkable photograph of *Figure 1b* shows the actual rise and fall time characteristics (inverted) of a fast pulse of

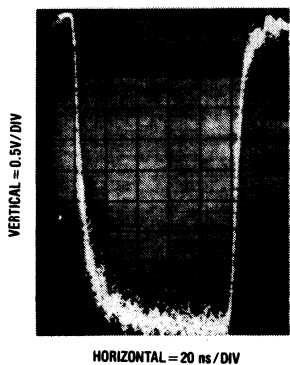


FIGURE 1b

TL/H/5641-2

light produced by an LED. This photo was taken with a high speed PMT which was terminated directly into a 1 GHz bandwidth, 50 Ω sampling oscilloscope.

Another PMT application exchanges speed for sensitivity in a nuclear medical instrument, the Gamma camera.

The Gamma camera operates by using the scintillation properties of special crystals which are placed in front of an array of PMTs. Small quantities of radioactive isotopes are introduced into the patient either by oral ingestion or injection. Specific isotopes collect at certain organs within the body. As the radioactive isotopes decay, gamma rays are emitted from the isotope concentration area. These rays are collimated by a lead plate containing many small holes which forms the front of the camera (*Figure 2a*). This collimator allows only those rays which are at right angles to pass through the plate. The rest are absorbed in the lead. In this fashion the geometric shape of the gamma source is preserved and is presented to the scintillation crystal. The array of PMTs is located behind the crystal. The individual tubes respond to any given scintillation anywhere in the crystal with a distribution of signal strengths. This distribution is used by a processor to determine the precise point of scintillation in the crystal. Each of these scintillation locations is recorded on a CRT. After a length of time, this counting-integration process produces a picture of the organ on the CRT. *Figure 2b* shows 7 such pictures of a pair of human lungs, taken 30 seconds apart over a 150 second period. In photo A, the administered radioactive isotope begins to collect in the lungs. In photo B, the lungs are saturated. During photos C, D, E, F and G, the isotope progressively decays. Normally, human lungs will clear after 120 seconds. This particular sequence shows evidence of an obstructive pulmonary disease which is most pronounced in the lower right lung.

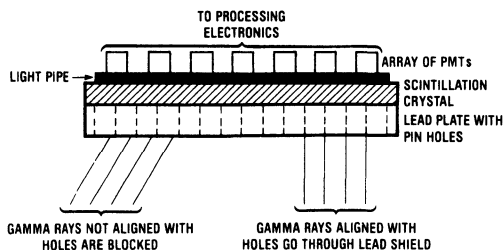


FIGURE 2a

TL/H/5641-3

PYROELECTRIC DETECTOR

The pyroelectric detector represents another class of sophisticated photodetector. These ceramic-based radiation detectors feature an extraordinary light sensitivity range from microwatts to watts with excellent linearity. Their bandwidth is flat from the ultraviolet to the far infrared. Response is sub-nanosecond and the devices may be operated at room temperature; no cooling is required. A major difficulty and source of confusion with signal conditioning pyroelectrics is that they do not respond at DC. This limitation, which is in keeping with all ceramic-based transducers, is surmounted by using a light chopper in front of the detector. In this fashion, DC light inputs to the detector appear as a modulated carrier. These devices are used in industrial temperature measurement, spectroscopy and laser power meters. They are also used to measure high speed laser pulse characteristics.

For signal conditioning purposes, pyroelectrics can be modeled as either a current source with parallel capacitance or a voltage source with series capacitance. Because there is no resistive component, there is no resistive Johnson noise. *Figure 3a* shows a simple voltage mode set-up which can be used for fast pulses of high energy. In this circuit, the detector is terminated directly into a high speed 50Ω oscilloscope. In *Figure 3b*, a slower detector terminates into 1 MΩ and is unloaded by the LH0052 low bias FET amplifier. For

response time much longer than a few milliseconds, the optical chopper provides a modulated light signal to the detector. The amplifier output may be rectified to recover the DC component of the signal. *Figure 3c* shows a current mode signal conditioning circuit. The optical chopper is retained, but the detector is loaded directly into the summing junction of a low bias op amp composed of an LF411 and a pair of sub-picoamp bias FETs. The low bias current allows low energy light measurement.

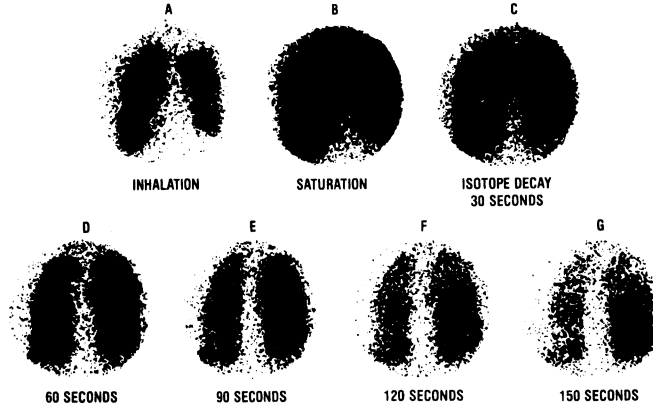


FIGURE 2b

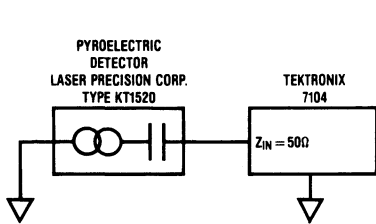


FIGURE 3a

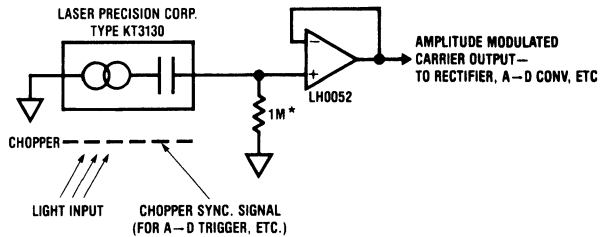
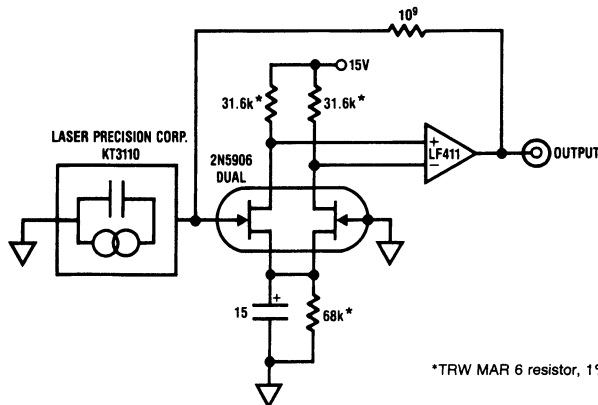


FIGURE 3b

*TRW MAR 6 resistor, 1%



*TRW MAR 6 resistor, 1%

FIGURE 3c

TL/H/5641-4

PIEZOELECTRIC ULTRASONIC RESONATORS

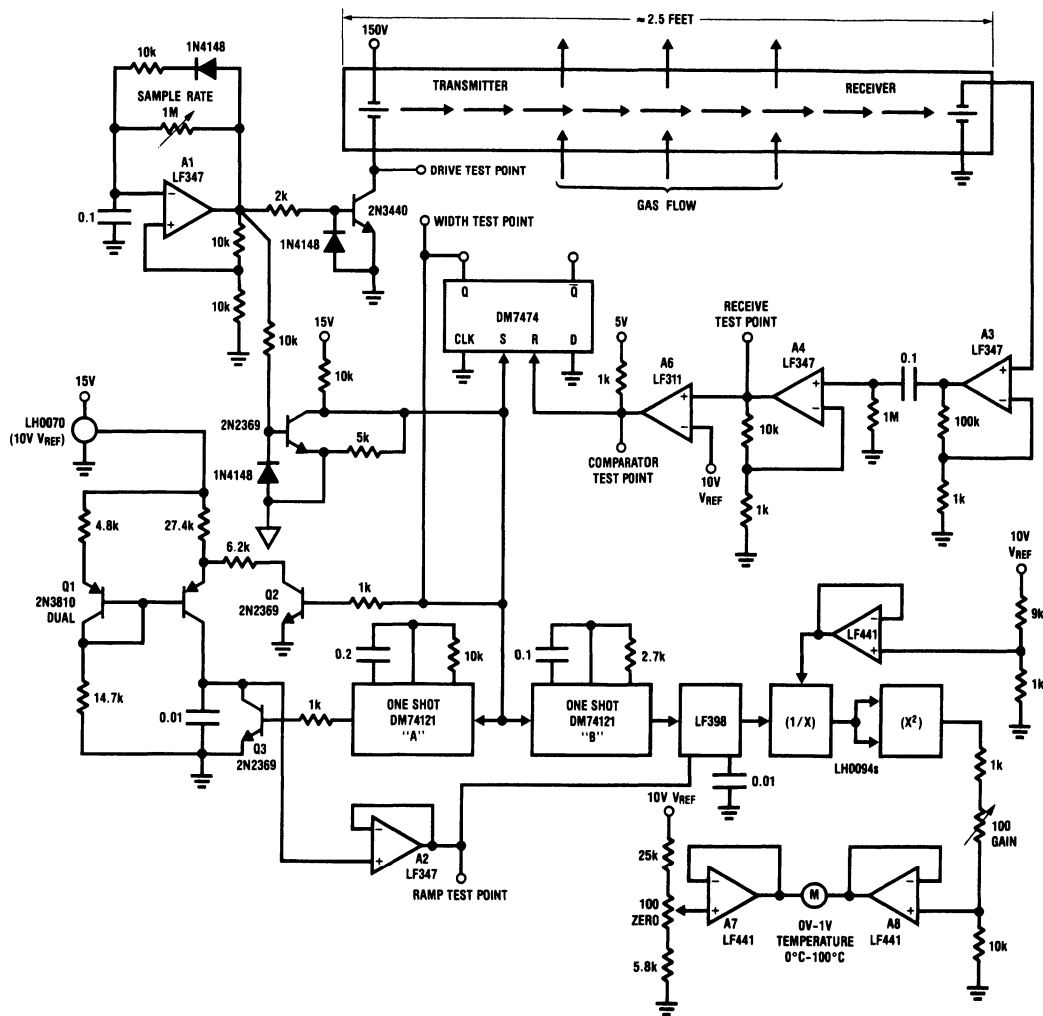
Piezoelectric ultrasonic transducers are generically related to pyroelectrics in that they are also ceramic-based. These devices are used for both generation and reception of narrow band ultrasonic information. The characteristic resonance of these transducers, in a similar fashion to quartz crystals, is extremely narrow, allowing high Q, noise rejecting systems to be built around them. As transmitters, they are often driven very hard by steps several hundred volts high at low duty cycles. This permits substantial ultrasonic power to be generated and eases the burden of the receiver in the system (which could be the same transducer as the transmitter). Ultrasonic resonators are used in a wide variety of applications including liquid level detection, intrusion alarms, automatic camera focusing, cardiac ultrasonic profiling (echocardiography) and distance measuring equipment. *Figure 4a* shows a signal conditioning circuit which capitalizes on the

high Q, noise rejection characteristics and fast response of ultrasonic transducers to accomplish a difficult thermal measurement. This circuit is similar to a type developed to measure high speed temperature shifts in a gas medium.

In contrast to almost all other temperature sensors, it does not rely on its sensing element to come into thermal equality with the measurand. Instead, the relationship between the speed of sound and the temperature of the medium in which the sound is propagating is utilized to determine temperature. The speed of response is therefore very fast and the measurement is also non-invasive. The relationship between the speed of sound in any medium and temperature may be described by equations. As an example, the relationship in dry air is:

$$C = 331.5 \sqrt{\frac{T}{273}} \text{ meters/second,}$$

where C = speed of sound.



Ultrasonic transducers = Massa MK-109

FIGURE 4a

TL/H/5641-5

For any given value of C the absolute temperature is:

$$T = \frac{273}{(331.5)^2} \times C^2.$$

It is clear that because sound speed and the medium in which it travels have a predictable relationship, a temperature transducer can be composed of the medium itself. If the characteristics of the medium can be defined (e.g., its make up) the transmit time of a sonic pulse through it can be used to determine its temperature. If narrow band ultrasonic transducers are used, they will reject sonic noise that may be occurring in the medium.

A1 periodically generates a short pulse (waveform A, *Figure 4b*) that drives the 2N3440 into conduction, forcing the ultrasonic 40 kHz transducer to emit a short burst at its resonant frequency. The 150V pulse amplitude allows substantial ultrasonic energy to be coupled into the medium. As this pulse is generated, the DM7474 flip-flop is set low (waveform C, *Figure 4b*). After a length of time, determined by the distance between the ultrasonic transducers and the temperature of the gas, the sonic pulse arrives at the receiving transducer and is amplified by A3 and A4 (A4's output is waveform B, *Figure 4b*). This amplified output triggers A6, which resets the flip-flop high. During the time the flip-flop was low, the 2N3810 current source was allowed to charge the 0.01 μ F capacitor (waveform D, *Figure 4b*). When the flip-flop is reset high, Q2 comes on and the charging ceases. The A2 follower output sits at the capacitor's DC potential, which is related to the sonic transit time in the gas stream. The LF398 sample-and-hold is triggered by the "B" DM74121 one shot and samples A2's output. The LF398's output feeds two LH0094 multi-function non-linear converters which are arranged to linearize the speed of sound versus temperature relationship. The output of this configuration is the gas temperature which is displayed on the meter. Gain and zero trims are provided via the A7 and A8 networks. When A1 issues another pulse, the DM74121 "A" one shot resets the 0.01 μ F capacitor to 0V and the entire process repeats.

It is worth noting that no bandwidth limiting of any kind is employed at the A3-A4 receiver despite their compound gain of 1000. This would seem to invite noise sensitivity problems in a sonic system, but the high Q ultrasonic transducer provides almost ideal noise rejection. *Figure 4c* shows the amplified output of the received pulse superimposed on the output of a boardband microphone placed in the sonic path. Boardband noise 100 dB greater than the 40 kHz pulse is pumped into the sonic path. Virtually complete noise rejection occurs and signal integrity is maintained.

PIEZOELECTRIC ACCELEROMETER

Another piezoelectric-based transducer is the piezoelectric accelerometer. These devices utilize the property of certain ceramic materials to produce charge when subject to mechanical excitation. These accelerometers use a mass coupled to the piezoelectric element to generate a force on the element in response to an acceleration's frequency and amplitude. Calibration and sensitivity can be varied by selecting the piezoelectric material and altering the configuration and amount of the mass. The best way to signal condition these devices is to employ an amplifier configuration that is directly sensitive to their charge-type output. Charge amplifiers use low bias current op amps with capacitive feedback. Output voltage will depend upon the charge out of the accelerometer which is related to the applied acceleration.

In *Figure 5a*, the transducer looks directly into the ground potential summing junction of an op amp. Because of this, there is no voltage difference between the interconnecting cable center conductor and its shield. This eliminates cable capacitance effects on the transducer output and allows long cable runs. It is advisable to use cable specified for low triboelectric charge effects for best performance, although this is usually only a factor with relatively low output devices. The $10^{11}\Omega$ resistor provides a DC feedback path, while the variable capacitor sets the sensitivity of the charge-to-voltage conversion. When the accelerometer shown is mounted on a hand-held voltmeter and dropped on the floor, the instantaneous acceleration to which the voltmeter is subjected can be determined. In *Figure 5b*, the stored trace display

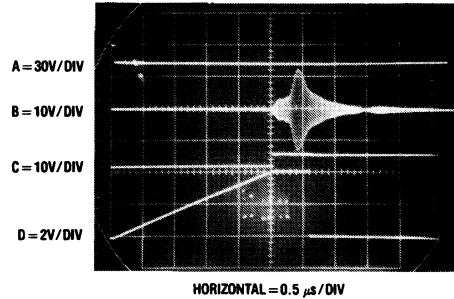


FIGURE 4b

TL/H/5641-6

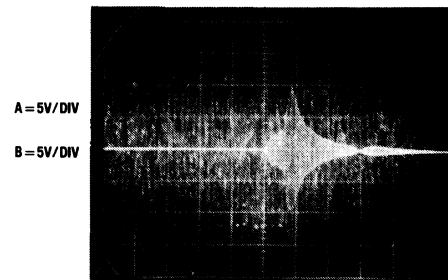


FIGURE 4c

TL/H/5641-7

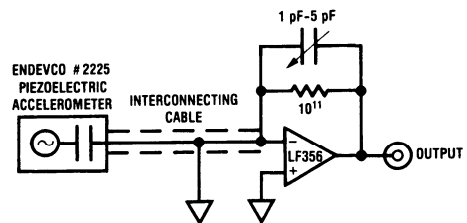
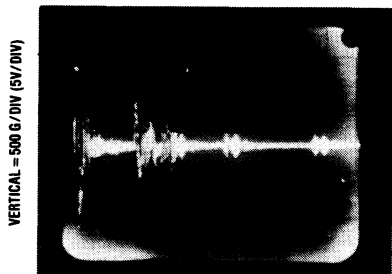


FIGURE 5a

TL/H/5641-8

shows an instantaneous force of almost 1000G with smaller forces generated as the voltmeter bounces 3 times over 60 ms. (It is recommended that this experiment be performed with a borrowed voltmeter.)



HORIZONTAL = 10 ms/DIV

TL/H/5641-9

FIGURE 5b

LINEAR VARIABLE DIFFERENTIAL TRANSFORMER (LVDT)

The linear variable differential transformer (LVDT) offers zero-friction position sensing with good precision. Although potentiometers are easy to signal condition and allow high precision they cannot match the nearly infinite life and zero-friction of the LVDT approach. LVDTs are available in both rotary and stroke mechanical configurations. The LVDT is basically a transformer (Figure 6a) with a movable core. The primary is driven with a sine wave which is usually amplitude stabilized. The two matched secondaries are connected in series-opposed fashion. When the movable core is positioned in the magnetic (and usually geometric) center of the transformer, the secondaries' outputs cancel and no net secondary voltage appears. This is called the null position. As the core is moved from null, the differential in flux coupled to the two secondaries produces a net voltage difference across them.

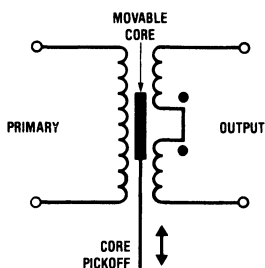


FIGURE 6a

TL/H/5641-10

This is the output of transducer. Good transducer performance (e.g., null cancellation characteristics, linearity, etc.) requires manufacturer attention to winding techniques, magnetic shielding, material choices and other issues. Rectifying and filtering the output signal will yield only amplitude information. Optimum signal conditioning requires a phase sensitive demodulation scheme. This gives the amplitude and also polarity information necessary to determine on which side of null the LVDT core is.

Figure 6b shows a circuit which does this. Waveforms of operation are given in Figure 6c. In this circuit, Q1 and its associated components from a phase shift oscillator which runs at 2.5 kHz, the manufacturer's specified transducer operating frequency. A1A amplifies and buffers Q1's output and drives the LVDT (waveform A, Figure 6c). Since the transducer's output will vary with drive level, feedback is used to stabilize the 2.5 kHz amplitude. A1C and A1D full wave rectify a sample of the drive waveform. A1C's filtered output is applied to A1D, a servo amplifier. A1D compares A1C's output to the LM329 reference and drives the Q1 oscillator to complete an amplitude stabilization loop. The LVDT's output is amplified by A2C and fed to A2A. A2A is a unity gain amplifier whose sign alternates between "+" and "-". Synchronous switching for A2A comes from C1 (waveform B, Figure 6c), which is driven by the modulation sine wave output via a phase shift network. The phase trim network compensates phase shift in the LVDT and ensures that C1 switches at the zero crossings relative to A2A's output. When C1's output is low, the 2N4393 FET is off and A2A's positive input (waveform C, Figure 6c) receives signal. When the sine wave reverses polarity, C1's output goes high, turning on the FET, which grounds A2A's "+" input. Under these conditions A2A is always switching its amplification's sign from "+" to "-" in synchronism with the sine wave output from the LVDT. A2A's phase sensitive output, in this case positive, appears in trace D, Figure 6c. A2B provides a scaled and filtered DC output. To trim the circuit, set the LVDT to at least 1/2 physical displacement and adjust the phase trim for maximum output indication. Next, adjust the gain trim for the desired circuit output at full-scale LVDT displacement.

FORCE-BALANCED PENDULOUS ACCELEROMETER

The operating principles of the LVDT are applied in the force-balanced pendulous accelerometer. Transducers of this type feature wide dynamic range, high linearity and very high accuracy. Figure 7a shows one form of a conceptual force-balanced pendulous accelerometer. The device operates by using an LVDT-type pick-off to determine the position of the pendulum. The DC output of the LVDT is fed to a servo amplifier which drives the torque coil. The magnetic output of the torque coil completes a servo loop around the pendulum, forcing it to become immobile. Because the torque coil's field can attract only the pendulum, a second bias coil provides a steady force for the torque coil to work against. When an input acceleration occurs along the sensitive axis, the servo applies the necessary current to the torque coil to keep the pendulum from moving. The amount of current required is directly proportional to the value of the input acceleration. Because the pendulum never moves, transducer linearity and accuracy can be very high. In addition, wide dynamic range is possible. Force-balanced accelerometers are widely applied in aircraft inertial guidance systems, aerospace applications, seismic monitoring, shock and vibration studies, oil drilling platform stabilization and similar applications. In recent years these accelerometers have become available in complete signal conditioned packages, although there are a number of applications where it is desirable to independently signal condition the transducer. Figure 7b shows a detailed schematic of such signal conditioning. The pick-off circuitry is similar to the LVDT shown in Figure 6b and does not require further comment. The bias coil is driven by the LH0002 boosted LF347 (A1A) which is in a current sensing feedback configuration. For the accelerometer shown, the manufacturer specifies

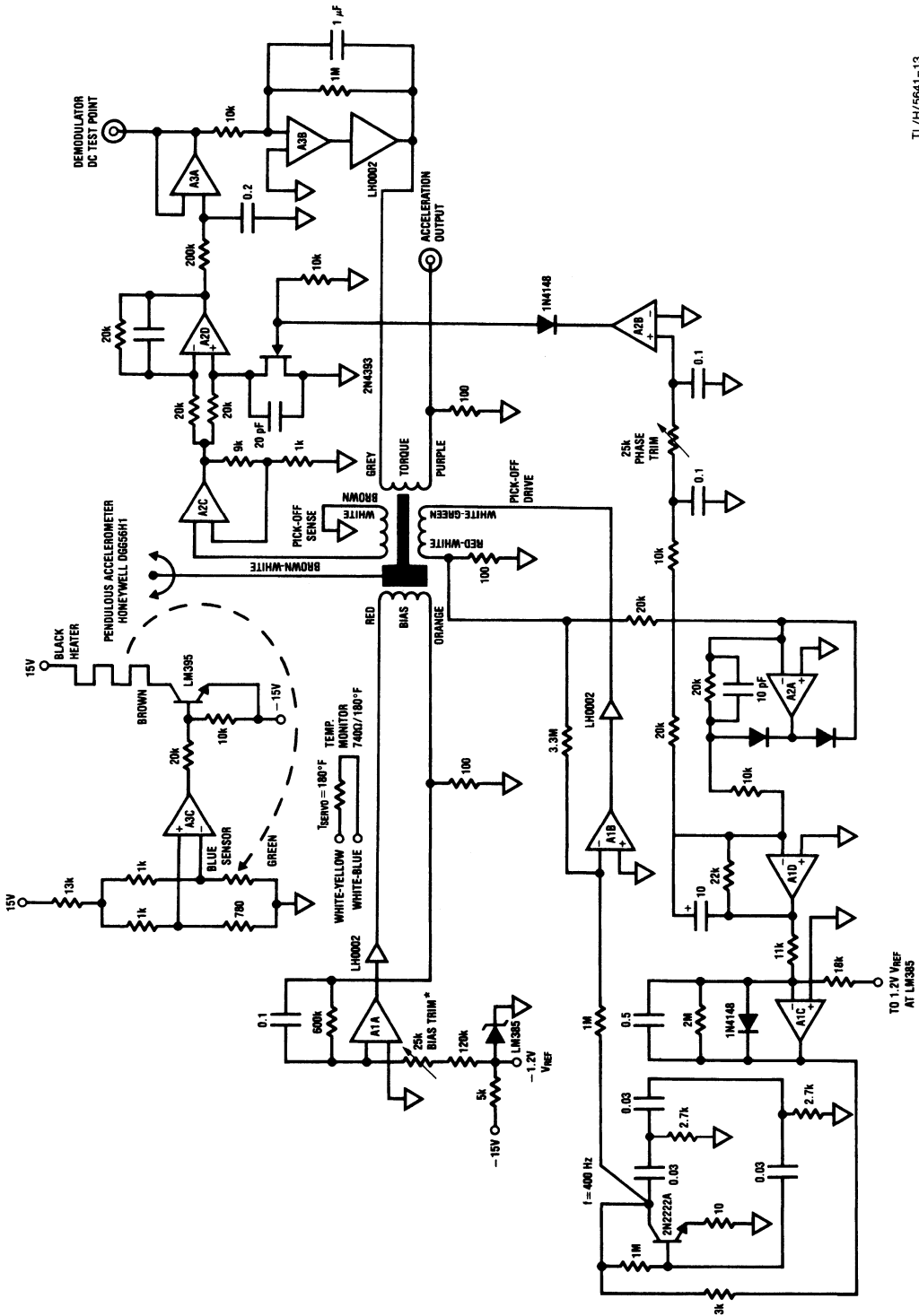


FIGURE 7b

TL/H/9641-13
 *Adjust to 60 mA bias loop current
 A1, A2, A3 = LF347

RATE GYRO

The rate gyro is another form of high performance inertial measuring transducer. It consists of an electrically driven gyroscope with a captive spin axis. Normal gyros are free of restraint and maintain position when moved. The rate gyro is held captive and forced to move with the physical input. By measuring the force generated as the gyro opposes its restraining mechanism, rate-of-angle change information can be deduced. *Figure 8* shows signal conditioning for a typical rate gyro. An LVDT-type pick-off is used and synchronous demodulation-type circuitry very similar to *Figure 7b* is employed. Note the high voltage drive to the gyro motor (26 Vrms) supplied by the boosted LM143. Because of their long life and high precision rate, gyros are frequently employed in inertial guidance systems, drilling platform stabilization systems and other critical applications.

FLUX GATE

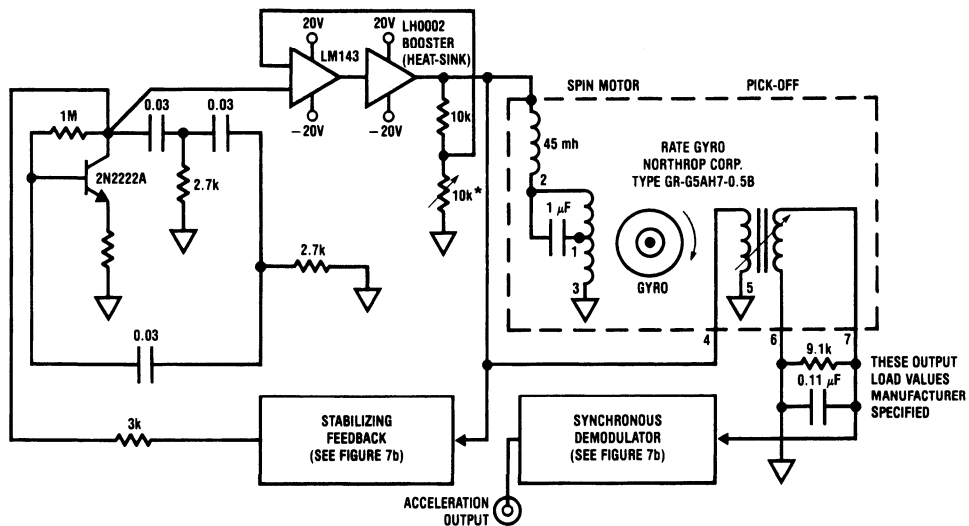
A flux gate transducer converts an external magnetic field (such as that of the earth's) into an electric output. A variety of flux gate configurations exist, the simplest being a piece of easily saturable ferrous material wrapped around a cylinder (*Figure 9a*). An alternating current is passed along the axis of the cylinder which periodically saturates the material, first clockwise and then counter-clockwise.

A pick-up winding is wrapped around the cylinder. While the ferrous material is between saturation extremes, it maintains a certain average permeability. While in saturation, this permeability ($\mu = dB/dH$) becomes one (an increase in driving field H produces the same increase in flux B). If there is no component of magnetic field along the axis of the cylinder, the flux change seen by the pick-up winding is zero since the excitation flux is normal to the axis of the winding. If, on the other hand, a field component is present along the cylindrical axis, then each time the ferrous material goes from one saturation extreme to the other it produces a pulse output on the signal pick-up winding that is proportional to the

external magnetic field and the average permeability of the material. Since this saturation-to-saturation transition occurs twice each excitation period (fundamental), the frequency of signal out of the pick-up windings is twice the excitation frequency.

These transducers find use in metal detectors, submarine locating gear, electronic compasses, oil surveys, and other areas where measurement of the strength or locally caused disturbance of the earth's magnetic field is of interest. Flux gate transducers are capable of measuring variations in the earth's magnetic field within one gamma (10^{-5} oersteds). Two axis flux gates can be used to construct an electronic compass. More recent flux gate design employs a core-shaped transducer, which is essentially two cylinder types bent together at the ends to form a closed magnetic path. This permits lower driving power and allows the use of commercially available tape-wound cores to be used to construct the transducer. A simple flux gate and its signal conditioning appears in *Figure 9b*. Excitation to the flux gate is provided by the complementary signal output from the CD4047s. The transistor drives a transformer which is tuned for resonance. This converts the square wave output of the CMOS oscillator into a sinusoidal waveform. This sinusoidal excitation voltage is then converted by the transformer into a high level AC drive current at the excitation frequency which is used to drive the sensor.

The output of the sensor signal winding is an AC signal at twice the excitation frequency and is directly proportional in amplitude to the external axial magnetic field. This second-harmonic of the excitation frequency is then phase detected with a circuit similar to the demodulators shown in *Figures 6b* and *7b*. A portion of the DC output signal may be fed back (shown in dashed lines) to the signal winding to provide a closed loop negative feedback system. This feedback signal produces a field in the sensor which opposes the signal being measured. The high forward gain of the signal channel along with the closed loop negative feedback system ensure good stability and linearity of the output signal.



*Adjust for 26 Vrms output

FIGURE 8

TL/H/5641-14

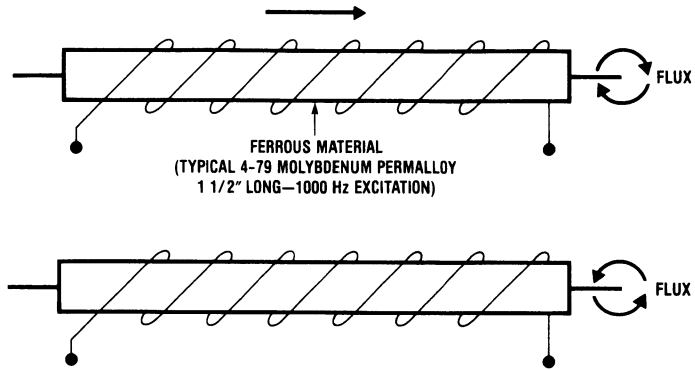


FIGURE 9a

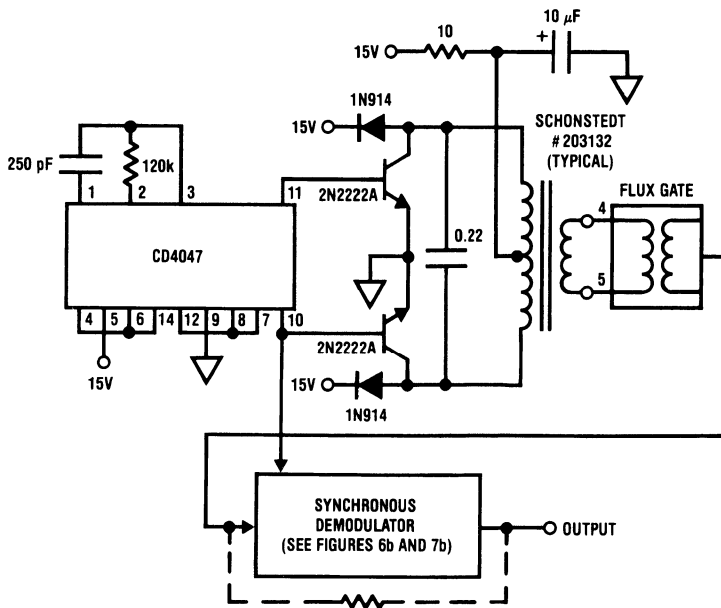


FIGURE 9b

TL/H/5641-15

LOW POWER STRAIN GAUGE BRIDGE SIGNAL CONDITIONING

In most cases, strain gauge bridges do not require unusual signal conditioning techniques. When low power consumption is necessary, special circuitry must be employed to eliminate the high current consumption of strain gauge-based transducers. Normally, the 350Ω input impedance of these devices requires substantial drive to achieve a usable output. For a typical 10V drive level, 35 mA are required; hardly compatible with low power or battery operation. The circuit shown in Figure 10a provides complete signal conditioning for strain gauge transducers while using only 1.8 mA average current out of a 9V transistor radio battery. The output of the circuit is an 8-bit word produced by an A-D converter. The key to achieving low power operation is to

pulse power at low duty cycles to the transducer and its signal conditioning circuitry. In Figure 10b, A1A oscillates at about 1 Hz. Each time A1A's output goes high (waveform A, Figure 10b), Q1 comes on, turning on the LM330 5V regulator. This places 5V at Q2's collector. Concurrently, A1B amplifies the output of the pulse-edge shaping network at its input and provides voltage overdrive to emitter-follower Q2, forcing it into saturation. This causes an edge shaped pulse to be applied to the strain gauge bridge (waveform B, Figure 10b). This pulse is also used to power A2 and the ADC0804 A-D converter. The slow edge shaping limits the DV/DT seen by the transducer as it is pulsed. This eliminates possible deleterious effects on transducer performance over time, due to the continuous abrupt step functions being applied. The transducer bridge output is monitored by the A2 quad, which serves as a differential input (A2A and A2B),

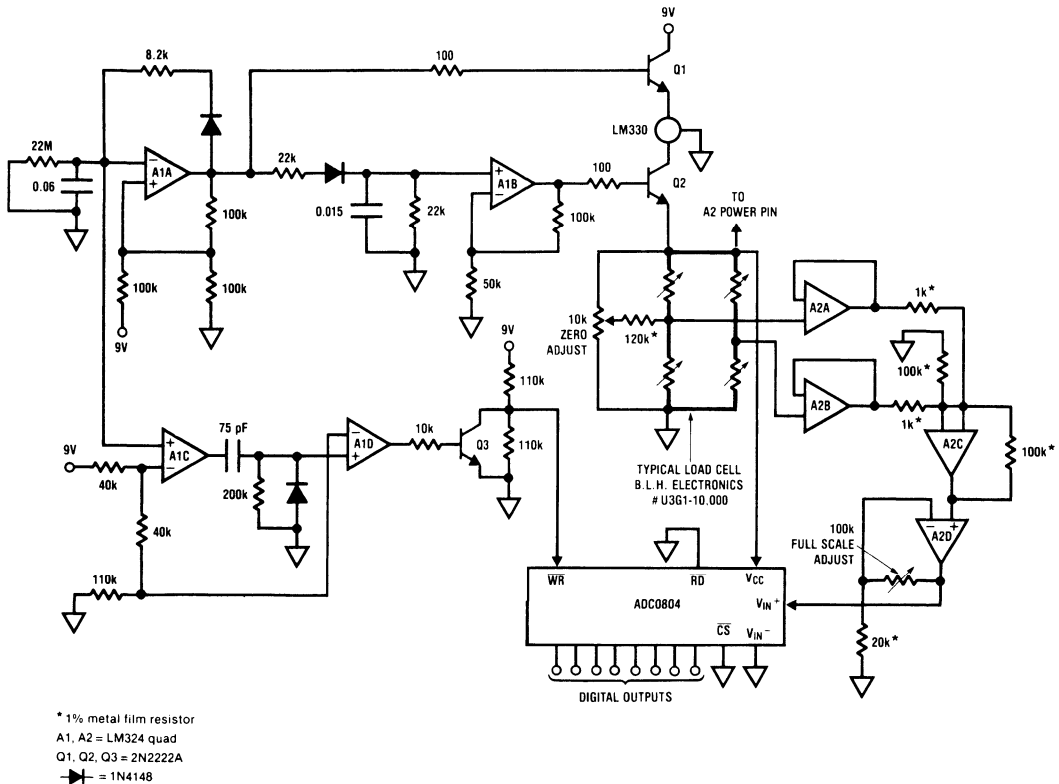


FIGURE 10a

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single-ended output (A2C and A2D) amplifier. A2D's output (waveform C, *Figure 10b*) feeds the ADC0804 A-D converter. The A-D is triggered by a delayed pulse generated by the A1C and A1D pair (waveform D, *Figure 10b*). This pulse is positioned so that it occurs after A2D's output has settled to final value. To calibrate the circuit, apply zero physical load to the transducer shown and adjust the zero trim so the A-D converter is just below indicating 1 LSB output. Next, apply (or electrically simulate) 10,000 lbs. and adjust the gain trim for a full output code at the A-D converter.

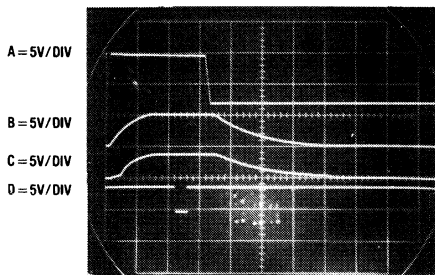


FIGURE 10b

TL/H/5641-17

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 RCA Electro-Optics Division
 Lancaster Radiology Associates

Introducing the MF10: A Versatile Monolithic Active Filter Building Block

National Semiconductor
Application Note 307
Tim Regan



A unique alternative for active filter designs is now available with the introduction of the MF10. This new CMOS device can be used to implement precise, high-order filtering functions with no reactive components required.

Filter design takes one of two approaches: passive or active. Passive designs combine resistors, capacitors and inductors to perform specific frequency filtering in applications where precision is less important than mass producibility. For very high frequency applications, a passive approach is quite often the only way to go. Active filters combine op amps and discrete transistors, primarily with resistors and capacitors, to provide impedance buffering and filter parameter tunability. In precision filters, it is most desirable to have an independent "handle" for each of three basic filter parameters: resonant frequency (f_0), Q or quality factor, and the passband gain (H_0). As a general rule, the degree of tunability increases with the number of amplifiers used. The three op amp, state variable active filter, *Figure 1*, is most popular for 2nd order designs.

A major shortcoming of this type of filter is that resonant frequency accuracy is only as good as the capacitors used. In high volume production, to minimize filter tuning procedures, costly, low-tolerance, low-drift capacitors are required. Furthermore, these filters use a fair number of components; 3 op amps, 7 resistors and 2 capacitors for each 2nd order section. Even the best single amplifier 2nd order filter realizations require 3 to 5 resistors and 2 capacitors.

To offer designers an attractive alternative to these types of active filters, a device would have to:

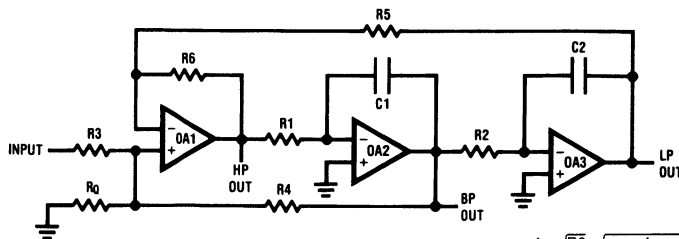
- 1) eliminate critical capacitors entirely
- 2) minimize overall parts count
- 3) provide easy tunability of filter parameters
- 4) allow for the design of all five filter responses and,
- 5) simplify design equations.

These are the design objectives behind the development of the MF10. Recent advances in sample-data techniques permit the construction of an op amp integrator on a monolithic substrate without the need for any external capacitors (see page 11 "The Switched Capacitor Integrator—How it Works"). The integrator is a key factor in filter designs for establishing the overall filter time constant and, therefore, its resonant frequency. The MF10 contains, in one 20-pin DIP package, all of the necessary active and reactive components to construct two complete 2nd order state variable type active filters, *Figure 2*. The only external requirements are for resistors to establish the desired filter parameters.

BASIC CIRCUIT DESCRIPTION

To keep the device as universal as possible, the outputs of each section of each filter are brought out. This allows designs for all five filtering functions: lowpass, bandpass, highpass, allpass and bandreject or notch filters. With two independent 2nd order sections in one package, cascading to achieve 4th order responses can easily be accomplished. Additionally, any of the classical filter response types such as Butterworth, Chebyshev, Bessel and Causer can be implemented.

Between the output of the summing op amp and the input of the first integrator there is a unique 3-input summing stage where two of the inputs are subtracted from the third. One of the (-) inputs is brought out to serve as the signal input for some filter configurations. The other (-) input is connected through an internal switch to either the lowpass output or analog ground depending upon the desired filter implementation. The direction of this input connection is common to both halves of the MF10 and is controlled by the voltage level on the $S_{A/B}$ input terminal.

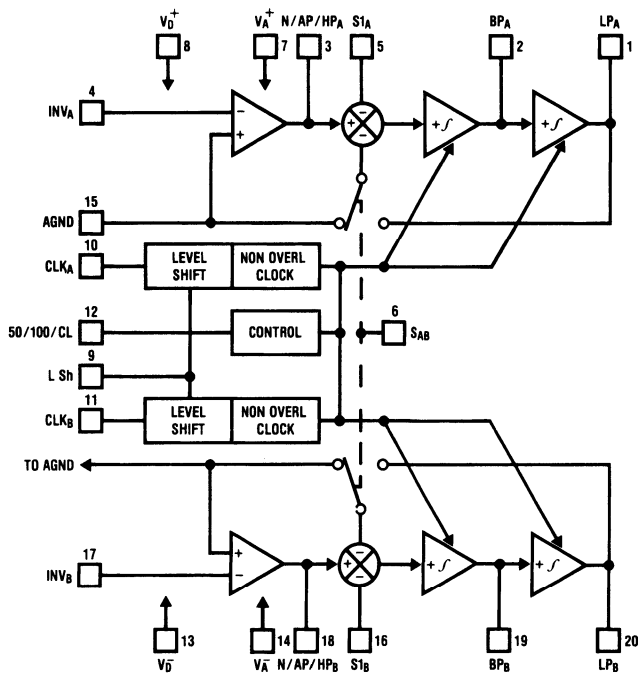


$$f_0 = \frac{1}{2\pi} \sqrt{\frac{R_6}{R_5}} \sqrt{\frac{1}{R_1 R_2 C_1 C_2}}$$

$$Q = \left(\frac{1 + \frac{R_4}{R_3} + \frac{R_4}{R_0}}{1 + \frac{R_6}{R_5}} \right) \sqrt{\frac{R_6 R_1 C_1}{R_5 R_2 C_2}}$$

TL/H/5035-1

FIGURE 1. The Universal State Variable 2nd Order Active Filter
(note the complexity of design equations and the number of critical external components)



TL/H/5035-2

FIGURE 2. Block Diagram of the MF10

When tied to V_D^+ [the (+) supply], the switch connects the lowpass output, and when tied to V_D^- [the (-) supply], the connection to ground is made. In some applications one half of the MF10 may require that both of the (-) inputs to this summer be connected to ground, while the other side requires one to be connected to the lowpass output and the other to ground. For this, the $S_{A/B}$ control should be tied to the (-) supply and the connection to the lowpass output should be made externally to the S_{1A} (S_{1B}) pin.

A clock with close to 50% duty cycle is required to control the resonant frequency of the filter. Either TTL or CMOS logic compatible clocks can be accommodated, whether the MF10 is powered from split supplies or a single supply, by simply grounding the level shift (L Sh) control pin.

The resonant frequency of each filter is directly controlled by its clock. A tri-level control pin sets the ratio of the clock frequency to the center frequency (the 50/100/CL pin) for both halves. When this pin is tied to V^+ the center frequency will be 1/50 of the clock frequency. When tied to mid-supply potential (i.e., ground, when biased from split supplies) provides 100 to 1 clock to center frequency operation. When this pin is tied to V^- a power saving supply current limiter shuts down operation and rolls back the supply current by 70%.

Filter center frequency accuracy and stability are only as good as the clock provided. Standard crystal oscillators, combined with digital counters, can provide very stable clocks for specific filter frequencies. A relatively new device from National's COPS family of microcontrollers and peripherals, the COP452 programmable frequency generator/counter, finds a unique use with the MF10, Figure 3. This low cost device can generate two independent 50% duty cycle clock frequencies. Each clock output is programmed

via a 16-bit serial data word (N). This allows over 64,000 different clock frequencies for the MF10 from a single crystal.

The MF10 is intended for use with center frequencies up to 20 kHz, and is guaranteed to operate with clocks up to 1 MHz. This means that for center frequencies greater than 10 kHz, the 50 to 1 clock control should be used. The effect of using 100 to 1 or 50 to 1 clock to center frequency ratio manifests itself in the number of "stair-steps" apparent in the output waveform. The MF10 closely approximates the time and frequency domain response of continuous filters (RC active filters, for example) but does so using sampling techniques. The clock to center frequency control determines the number of samples taken (1 per clock cycle) in one cycle of the center frequency. Therefore, as shown in the photo of Figure 4, 100 to 1 clocking provides a smoother looking output as it has twice as many samples per cycle. For most audio applications, the audible effects of these step edges and the clock frequency component in the output are negligible as they are beyond 20 kHz. To obtain a cleaner output waveform, a simple passive RC lowpass can be added to the output to serve as a smoothing filter without affecting the MF10 filtering action.

Several of the modes of operation (discussed in a later section) allow altering of the clock to center frequency ratio by an external resistor ratio. This can be used to obtain center frequencies of values other than 1/50 or 1/100 of the clock frequency. In multiple stage, staggered tuned filters, the center frequency of each stage can be set independently with resistors to allow the overall filter to be controlled by just one clock frequency.

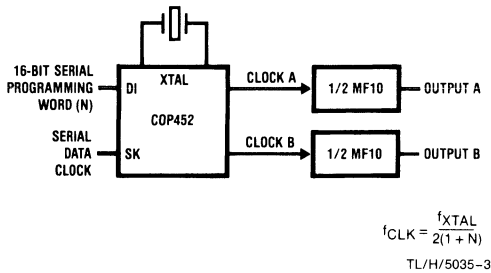


FIGURE 3. A Programmable Dual Clock Generator

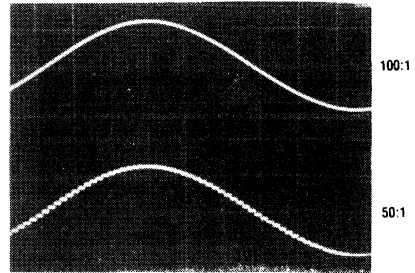
All of the rules of sampling theory apply when using the MF10. The sampling rate, or clock frequency, should be at least twice the maximum input frequency to produce the best equivalent to a continuous time filter. High frequency components in the input signal that approach the clock frequency will generate aliasing signals which appear at the output of the lower frequency filter and are indistinguishable from valid passband signals. Bandlimiting the input signal to attenuate these potential aliasing frequencies is the best preventative measure. In most applications, aliasing will not be a problem as the clock frequency is much higher than the passband of interest. In the event that a much higher clock frequency is required, the modes of operation which utilize external resistor ratios to increase the clock to center frequency ratio can extend the clock frequency to greater than 100 times the center frequency. By using a higher clock frequency, the aliasing frequencies are correspondingly higher. The limiting factor, with regard to increasing the clock to center frequency ratio, has to do with increased DC offsets at the various outputs.

THE BASIC FILTER CONFIGURATIONS

There are six basic configurations (or modes of operation) for the 2nd order sections in the MF10 to realize a wide variety of filter responses. In all cases, no external capacitors are required. Design is a simple matter of establishing a few resistor ratios to set the desired passband gain and Q and generating a clock for the proper resonant frequency. Each 2nd order section can be treated in a modular fashion, with regard to individual center frequency, Q and gain, when cascading either the two sections within a package or several packages for very high order filters. This individuality of sections is important in implementing the various response characteristics such as Butterworth, Chebyshev, etc.

The following is a general summary of design hints common to all modes of operation.

- 1) The maximum supply voltage for the MF10 is $\pm 7V$ or just + 14V for single supply operation. The minimum supply to properly bias the part is 8V.



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FIGURE 4. The Sampled-Data Output Waveform

- 2) The maximum swing at any of the outputs is typically within 1V of either supply rail.
- 3) The internal op amps can source 3 mA and sink 1.5 mA. This is an important criterion when selecting a minimum resistor value.
- 4) The maximum clock frequency is typically 1.5 MHz.
- 5) To insure the proper filter response, the $f_0 \times Q$ product of each stage must be realizable by the MF10. For center frequencies less than 5 kHz, the $f_0 \times Q$ product can be as high as 300 kHz (Q must be less than or equal to 150). A 3 kHz bandpass filter, for example, could have a Q as high as 100 with just one section. For center frequencies less than 20 kHz, the allowable $f_0 \times Q$ product is limited to 200 kHz. A 10 kHz bandpass design using a single section should have a Q no larger than 20.
- 6) Center frequency matching from part to part for a given clock frequency is typically $\pm 0.2\%$. Center frequency drift with temperature (excluding any clock frequency drift) is typically ± 10 ppm/ $^{\circ}C$ with 50:1 switching and ± 100 ppm/ $^{\circ}C$ for 100:1.
- 7) Q accuracy from part to part is typically $\pm 2\%$ with a temperature coefficient of ± 500 ppm/ $^{\circ}C$.
- 8) The expressions for circuit dynamics given with each of the modes are important. They determine the voltage swing at each output as a function of the circuit Q. A high Q bandpass design can generate a significant peak in the response at the lowpass output at the center frequency.
- 9) Both sides of the MF10 are independent, except for supply voltages, analog ground, clock to center frequency ratio setting and internal switch setting for the three input summing stage.

In the following descriptions of the filter configurations, f_0 is the filter center frequency, H_0 is the passband gain and Q is the quality factor of the complex pole pair and is equal to f_0/BW where BW is the -3 dB bandwidth measured at the bandpass output.

MODE 1A: Non-Inverting Bandpass, Inverting Bandpass, Lowpass

This is a minimum external component configuration (only 2 resistors) useful for low Q lowpass and bandpass applications. The non-inverting bandpass output is necessary for minimum phase filter designs.

Design Equations

$$f_o = \frac{f_{CLK}}{100} \text{ or } \frac{f_{CLK}}{50}$$

$$Q = \frac{R3}{R2}$$

$$H_{OLP} = -1$$

$$H_{OBP1} = -\frac{R3}{R2}$$

$$H_{OBP2} = 1 \text{ (non-inverting)}$$

Circuit Dynamics

$H_{OBP1} = -Q$ (this is the reason for the low Q recommendation)

$$H_{OLP}(\text{peak}) = Q \times H_{OLP}$$

MODE 1: Notch, Bandpass and Lowpass

With the addition of just one more external resistor, the output dynamics are improved over Mode 1A to allow bandpass designs with a much higher Q. The notch output features equal gain above and below the notch frequency.

Design Equations

$$f_o = \frac{f_{CLK}}{100} \text{ or } \frac{f_{CLK}}{50}$$

$$f_{\text{notch}} = f_o$$

$$Q = \frac{R3}{R2}$$

$$H_{OLP} = -\frac{R2}{R1}$$

$$H_{OBP} = -\frac{R3}{R1}$$

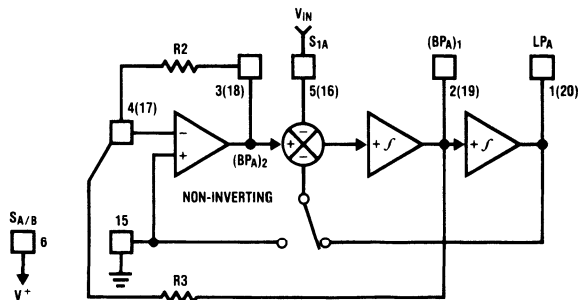
$$H_{ON} = -\frac{R2}{R1} \text{ as } f \rightarrow 0 \text{ and as } f \rightarrow \frac{f_{CLK}}{2}$$

Circuit Dynamics

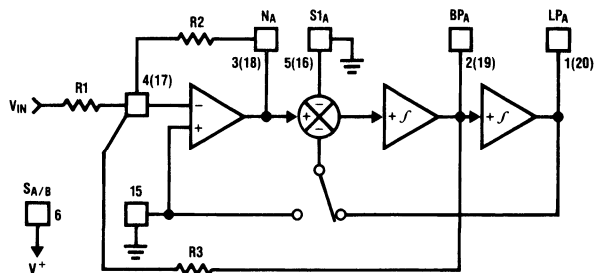
$$H_{OBP} = H_{OLP} \times Q = H_{ON} \times Q$$

$H_{OLP}(\text{peak}) = Q \times H_{OLP}$ (if the DC gain of the LP output is too high, a high Q value could cause clipping at the lowpass output resulting in gain non-linearity and distortion at the bandpass output).

MODE 1A



MODE 1



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MODE 2: Notch (with $f_n \leq f_o$), Bandpass and Lowpass

This configuration allows tuning of the clock to center frequency ratio to values greater than 100 to 1 or 50 to 1. The notch output is useful for designing elliptic highpass filters because the frequency of the required complex zeros (f_{notch}) is less than the frequency of the complex poles (f_o).

Design Equations

$$f_o = \frac{f_{CLK}}{100} \sqrt{1 + \frac{R2}{R4}} \text{ or } \frac{f_{CLK}}{50} \sqrt{1 + \frac{R2}{R4}}$$

$$f_n = \frac{f_{CLK}}{100} \text{ or } \frac{f_{CLK}}{50}$$

$$Q = \sqrt{1 + \frac{R2}{R4}} \times \frac{R3}{R2}$$

$$H_{OLP} = \frac{-\frac{R2}{R1}}{1 + \frac{R2}{R4}}$$

$$H_{OBP} = -\frac{R3}{R1}$$

$$H_{ON1} \text{ (as } f \rightarrow 0) = \frac{-\frac{R2}{R1}}{1 + \frac{R2}{R4}}$$

$$H_{ON2} \text{ (as } f \rightarrow \frac{f_{CLK}}{2}) = -\frac{R2}{R1}$$

Circuit Dynamics

$$H_{OBP} = Q \sqrt{H_{OLP} \times H_{ON2}} = Q \sqrt{H_{ON1} \times H_{ON2}}$$

MODE 3: Highpass, Bandpass and Lowpass

This configuration is the classical state variable filter (the circuit of *Figure 1*) implemented with only 4 external resistors. This is the most versatile mode of operation, since the clock to center frequency ratio can be externally tuned either above or below the 100 to 1 or 50 to 1 values. The circuit is suitable for multiple stage Chebyshev filters controlled by a single clock.

Design Equations

$$f_o = \frac{f_{CLK}}{100} \sqrt{\frac{R2}{R4}} \text{ or } \frac{f_{CLK}}{50} \sqrt{\frac{R2}{R4}}$$

$$Q = \sqrt{\frac{R2}{R4}} \times \frac{R3}{R2}$$

$$H_{OHP} = -\frac{R2}{R1}$$

$$H_{OBP} = -\frac{R3}{R1}$$

$$H_{OLP} = -\frac{R4}{R1}$$

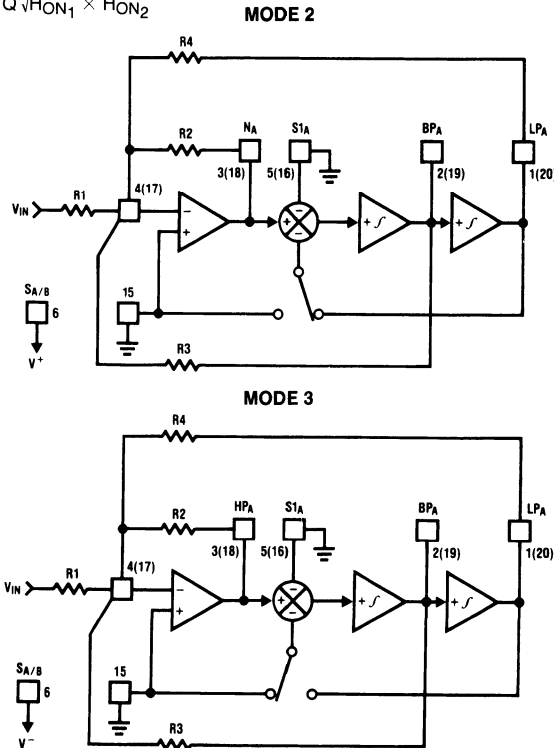
Circuit Dynamics

$$H_{OHP} = H_{OLP} \left(\frac{R2}{R4} \right)$$

$$H_{OLP} \text{ (peak)} = Q \times H_{OLP}$$

$$H_{OBP} = Q \sqrt{H_{OHP} \times H_{OLP}}$$

$$H_{OHP} \text{ (peak)} = Q \times H_{OHP}$$



TL/H/5035-6

MODE 3A: Highpass, Bandpass, Lowpass and Notch

A notch output is created from the circuit of Mode 3 by summing the highpass and lowpass outputs through an external op amp. The ratio of the summing resistors R_h and R_l adjusts the notch frequency independent of the center frequency. For elliptic filter designs, each stage combines a complex pole pair (at f_o) with a complex zero pair (at f_{notch}) and this configuration provides easy tuning of each of these frequencies for any response type. When cascading several stages of the MF10 the external op amp is needed only at the final output stage. The summing junction for the intermediate stages can be the inverting input of the MF10 internal op amp.

Design Equations

$$f_o = \frac{f_{CLK}}{100} \sqrt{\frac{R_2}{R_4}} \text{ or } \frac{f_{CLK}}{50} \sqrt{\frac{R_2}{R_4}}$$

$$Q = \sqrt{\frac{R_2}{R_4}} \times \frac{R_3}{R_2}$$

$$f_{notch} = \frac{f_{CLK}}{100} \sqrt{\frac{R_h}{R_l}} \text{ or } \frac{f_{CLK}}{50} \sqrt{\frac{R_h}{R_l}}$$

$$H_{OHP} = -\frac{R_2}{R_1}$$

$$H_{OLP} = -\frac{R_4}{R_1}$$

$$H_{OBP} = -\frac{R_3}{R_1}$$

$$H_{ON} \text{ (at } f = f_o) = \left| Q \left(\frac{R_g}{R_l} H_{OLP} - \frac{R_g}{R_h} H_{OHP} \right) \right|$$

$$H_{ON_l} \text{ (as } f \rightarrow 0) = \frac{R_g}{R_l} \times H_{OLP}$$

$$H_{ON_h} \text{ (as } f \rightarrow \frac{f_{CLK}}{2}) = \frac{R_g}{R_h} \times H_{OHP}$$

MODE 4: Allpass, Bandpass and Lowpass

Utilizing the S_{1A} (S_{1B}) terminal as a signal input, an allpass function can be obtained. An allpass can provide a linear phase change with frequency which results in a constant time delay. This configuration restricts the gain at the allpass output to be unity.

Design Equations

$$f_o = \frac{f_{CLK}}{100} \text{ or } \frac{f_{CLK}}{50}$$

$$f_z \text{ (frequency of complex zero pair)} = f_o$$

$$Q = \frac{R_3}{R_2}$$

$$Q_z \text{ (Q of complex zero pair)} = \frac{R_3}{R_1}$$

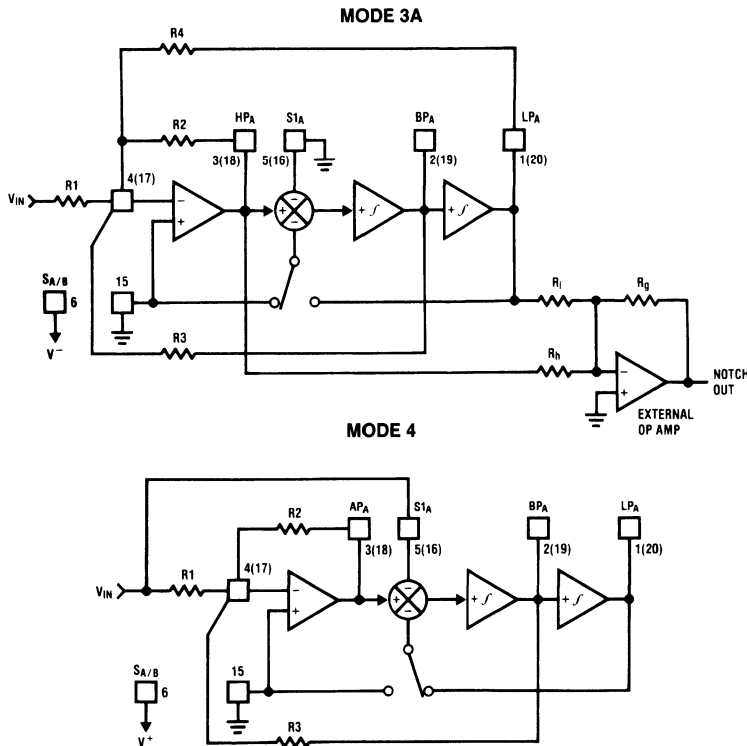
$$H_{OAP} = -\frac{R_2}{R_1} = -1$$

$$H_{OLP} = -\left(\frac{R_2}{R_1} + 1 \right) = -2$$

$$H_{OBP} = -\left(1 + \frac{R_2}{R_1} \right) \frac{R_3}{R_2} = -2 \frac{R_3}{R_2}$$

Circuit Dynamics

$$H_{OBP} = H_{OLP} \times Q = (H_{OAP} + 1)Q$$



MODE 5: Complex Zeros (C.z), Bandpass and Lowpass

This mode features an improved allpass design over that of Mode 4, in that it maintains a more constant amplitude with frequency at the complex zeros (C.z) output. The frequencies of the pole pair and zero pair are resistor tunable.

Design Equations

$$f_o = \frac{f_{CLK}}{100} \sqrt{1 + \frac{R2}{R4}} \text{ or } \frac{f_{CLK}}{50} \sqrt{1 + \frac{R2}{R4}}$$

$$f_z = \frac{f_{CLK}}{100} \sqrt{1 - \frac{R1}{R4}} \text{ or } \frac{f_{CLK}}{50} \sqrt{1 - \frac{R1}{R4}}$$

$$Q = \frac{R3}{R2} \sqrt{1 + \frac{R2}{R4}}$$

$$Q_z = \frac{R3}{R1} \sqrt{1 - \frac{R1}{R4}}$$

$$H_{O(C.z)} \text{ as } f \rightarrow 0 = \frac{R2(R4 - R1)}{R1(R2 + R4)}$$

$$H_{O(C.z)} \text{ as } f \rightarrow \frac{f_{CLK}}{2} = \frac{R2}{R1}$$

$$H_{OBP} = \frac{R3}{R2} \left(1 + \frac{R2}{R1} \right)$$

$$H_{OLP} = \frac{R4}{R1} \left(\frac{R2 + R1}{R2 + R4} \right)$$

MODE 6A: Single Pole, Highpass and Lowpass

By using only one of the internal integrators, this mode is useful for creating odd-ordered cascaded filter responses by providing a real pole that is clock tunable to track the resonant frequency of other 2nd order MF10 sections. The corner frequency is resistor tunable.

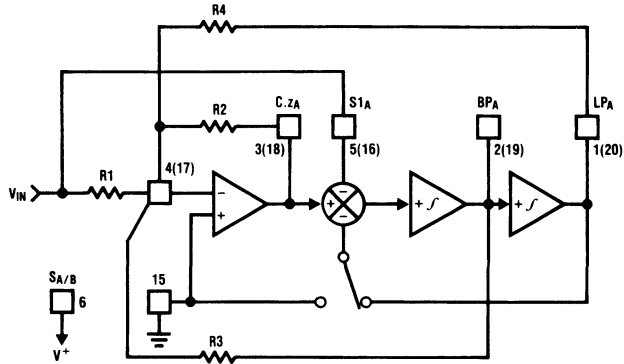
Design Equations

$$f_c \text{ (cut-off frequency)} = \frac{f_{CLK}}{100} \left(\frac{R2}{R3} \right) \text{ or } \frac{f_{CLK}}{50} \left(\frac{R2}{R3} \right)$$

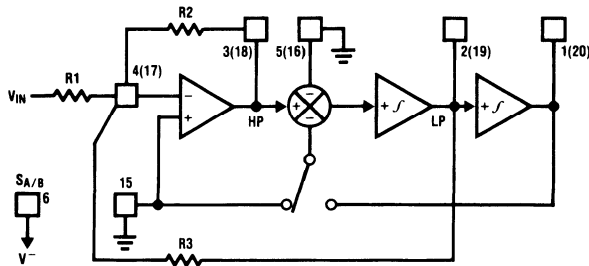
$$H_{OLP} = - \frac{R3}{R1}$$

$$H_{OHP} = - \frac{R2}{R1}$$

MODE 5



MODE 6A



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MODE 6B: Single Pole Lowpass (Inverting and Non-Inverting)

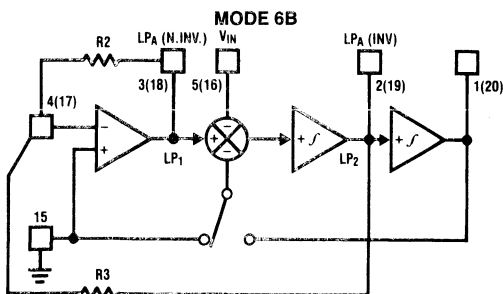
This mode utilizes only one of the integrators for a single pole lowpass, and the input op amp as an inverting amplifier, to provide non-inverting lowpass output. Again, this mode is useful for designing odd-ordered lowpass filters.

Design Equations

$$f_c \text{ (cut-off frequency)} = \frac{f_{CLK}}{100} \left(\frac{R2}{R3} \right) \text{ or } \frac{f_{CLK}}{50} \left(\frac{R2}{R3} \right)$$

$$H_{OLP} \text{ (inverting output)} = -\frac{R3}{R2}$$

$$H_{OLP} \text{ (non-inverting output)} = +1$$



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SOME SPECIFIC APPLICATION EXAMPLES

For single-supply operation, it is important for several terminals to be biased to half supply. A single-supply design for a 4th order 1 kHz Butterworth lowpass (24 dB/octave or 80 dB/decade rolloff) is shown using Mode 1 in Figure 5. Note that the analog ground terminal (pin 15), the summer inputs S1A and S1B (pins 5 and 16) and the clock switching control pin (pin 12) are all biased to V_{CC}/2. For symmetrical

split supply operation these pins would be grounded. An input coupling capacitor is optional, as it is needed only if the input signal is not also biased to V_{CC}/2. For a two-stage Butterworth response, both stages have the same corner frequency, hence the common clock for both sides. The resistor values shown are the nearest 5% tolerance values used to set the overall gain of the filter to unity and to set the required Q of the first stage (side A) to 0.504 and the second stage (side B) Q to 1.306 for a flat passband response.

A unique advantage of the switched capacitor design of the MF10 is illustrated in Figure 6. Here the MF10 serves double duty in a data acquisition system as an input filter for simple bandlimiting or anti-aliasing and, as a sample and hold to allow larger amplitude, higher frequency input signals. By gating OFF the applied clock, the switched capacitor integrators will hold the last sampled voltage value. The droop rate of the output voltage during the hold time is approximately 0.1 mV per ms.

A useful non-filtering application of the MF10 is shown in Figure 7. In this circuit, the MF10, together with an LM311 comparator, are used as a resonator to generate stable amplitude sine and cosine outputs without using AGC circuitry. The MF10 operates as a Q of 10 bandpass filter which will ring at its resonant frequency in response to a step input change. This ringing signal is fed to the LM311 which creates a square wave input signal to the bandpass to regenerate the oscillation. The bandpass output is the filtered fundamental frequency of a 50% duty cycle square wave. A 90° phase shifted signal of the same amplitude is available at the lowpass output through the second integrator in the MF10. The frequency of oscillation is set by the center frequency of the filter as controlled by the clock and the 50:1/100:1 control pin. The output amplitude is set by the peak to peak swing of the square wave input, which in this circuit is defined by the back to back diode clamps at the LM311 output.

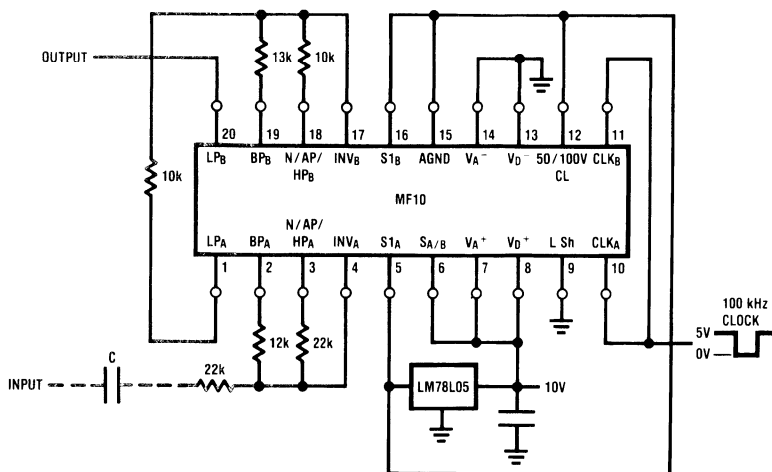


FIGURE 5. Only 6 resistors required for this 4th order, 1 kHz Butterworth lowpass filter. This example also illustrates single-supply biasing.

TL/H/5035-10

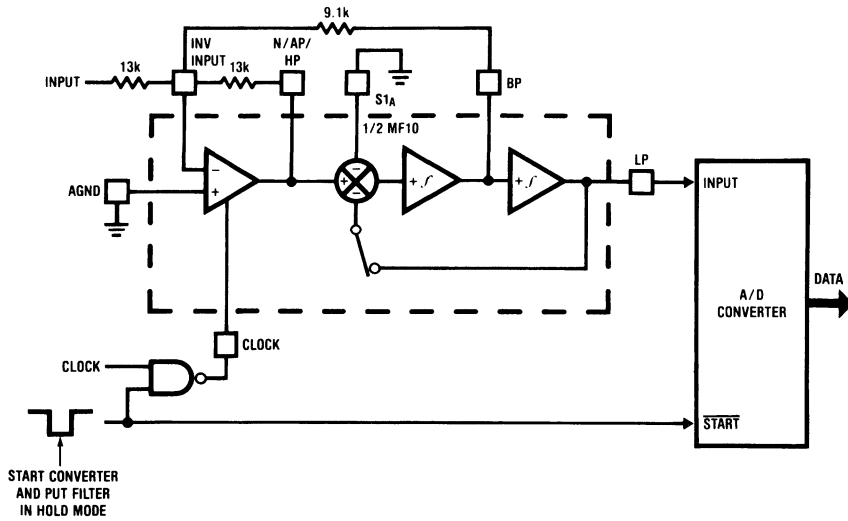


FIGURE 6. An MF10 as an Input Filter and Sample/Hold

TL/H/5035-14

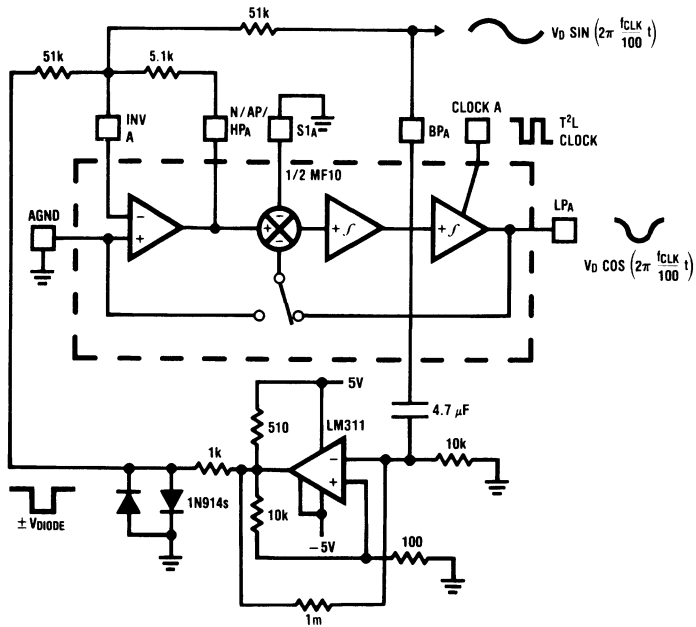


FIGURE 7. Generating Quadrature Sine Waves from a T²L Clock

TL/H/5035-11

Finally, as a graphic illustration of the simplicity of filter implementation using the MF10, *Figure 8* is a complete 300 baud, full-duplex modem filter. The filter is an 8th order, 1 dB ripple Chebyshev bandpass which functions as both an 1170 Hz originate filter and a 2125 Hz answer filter. Control of answer or originate operation is set by the logic level at the 50/100/CL input so that only one clock frequency is required. The overall filter gain is 22 dB.

Construction of this filter on a printed circuit board would obviously be more compact than an RC active filter approach and much more cost effective for the level of precision required. An even more attractive implementation from a space savings point of view would be a hybrid circuit approach. A film resistor array connecting to two MF10 die could produce the entire filter in one package requiring only 7 external connections for input, output, supplies, etc.

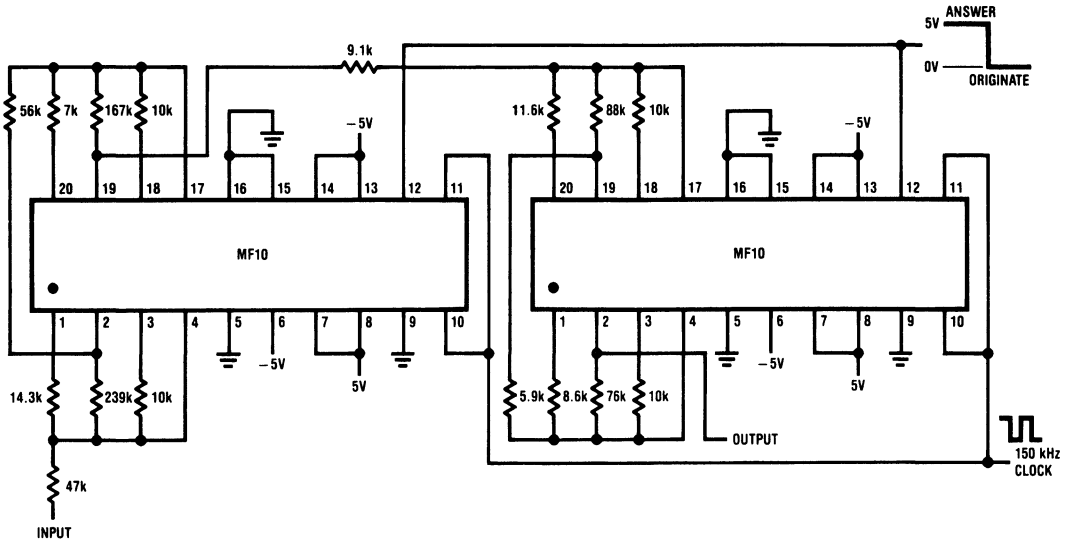


FIGURE 8. A Complete Full-Duplex 300 Baud Modem Filter

TL/H/5035-12

THE SWITCHED CAPACITOR INTEGRATOR—HOW IT WORKS

The most important feature of the MF10 is that it requires no external capacitors, yet can implement filters over a wide range of frequencies. A clock is used to control the time constant of two non-inverting integrators. To feel comfortable with the operation of the MF10, it is important to understand how this control is accomplished.

It is easiest to discuss an inverting integrator (*Figure A*) and how its input resistor can be replaced by 2 switches and a capacitor (*Figure B*). In *Figure A* the current which flows through feedback capacitor C is equal to V_{IN}/R and the circuit time constant is RC. This time constant accuracy depends on the absolute accuracy of two completely different discrete components. In *Figure B*, switches S1 and S2 are alternately closed by the clock. When switch S1 is closed (S2 is opened), capacitor C1 charges up to V_{IN} . At the end of half a clock period, the charge on C1 (QC1) is equal to $V_{IN} \times C1$. When the clock changes state, S1 opens and S2 closes. During this half of the clock period all of the charge on C1 gets transferred to the feedback capacitor C2.

The amount of charge transferred from the input, V_{IN} , to the summing junction [the (-) input] of the op amp during one complete clock period is $V_{IN}C1$. Recall that electrical current is defined as the amount of charge that passes through a conduction path during a specific time interval (1 ampere = 1 coulomb per second). For this circuit, the current which flows through C2 to the output is:

$$I = \frac{\Delta Q}{\Delta t} = \frac{V_{IN}C1}{T} = V_{IN}C1 f_{CLK}$$

where T is equal to the clock period.

The effective resistance from V_{IN} to the (-) input is therefore:

$$R = \frac{V_{IN}}{I} = \frac{1}{C1 f_{CLK}}$$

This means that S1, S2 and C1, when clocked in *Figure B*, act the same as the resistor in *Figure A* to yield a clock tunable time constant of:

$$\tau = \frac{C2}{C1 f_{CLK}}$$

Note that the time constant of the switched capacitor integrator is dependent on a *ratio* of two capacitor values, which, when fabricated on the same die, is very easy to control. This can provide precise filter resonant frequency control both from part to part and with changes in temperature.

The actual integrators used in the MF10 are non-inverting, requiring a slightly more elegant switching scheme, as shown in *Figure C*. In this circuit, S1_A and S1_B are closed together to charge C1 to V_{IN} . Then S2_A and S2_B are closed to connect C1 to the summing junction with the capacitor plates reversed, to provide the non-inverting operation. If V_{IN} is positive, V_{OUT} will move positive as C2 acquires the charge from C1.

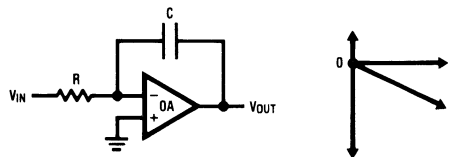


FIGURE A

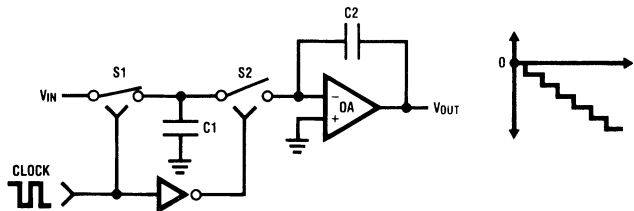


FIGURE B

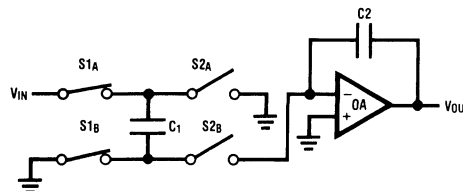


FIGURE C. The Non-Inverting Integrator Used in the MF10

TL/H/5035-13

Theory and Applications of Logarithmic Amplifiers

National Semiconductor
Application Note 311



AN-311

A number of instrumentation applications can benefit from the use of logarithmic or exponential signal processing techniques. The design and use of logarithmic/exponential circuits are often associated with involved temperature compensation requirements and difficult to stabilize feedback loops. For these considerations and others, designers tend to avoid these circuits. Hybrid and modular logarithmic/exponential devices are available commercially, but are quite expensive and earn very high profits for their manufacturers.

The theory and construction of these circuits are actually readily understood. *Figure 1* shows an amplifier which provides a logarithmic output for a linear input current or voltage. For input currents, the circuit will maintain 1% logarithmic conformity over almost 6 decades of operation. This circuit is based, as are most logarithmic circuits, on the inherent logarithmic relationship between collector current and V_{BE} in bipolar transistors. Q1A functions as the logging transistor in this circuit and is enclosed within A1A's feedback loop, which includes the 15.7 k Ω -1 k Ω divider. The circuit's input will force A1A's output to achieve whatever value is required to maintain its summing junction at zero potential. Because Q1A's response is dictated by the logarithmic relationship between collector current and V_{BE} , the output of A1A will be the logarithm of the circuit input. A1B and Q1B provide compensation for Q1A's V_{BE} temperature dependence. A1B servos Q1B's collector current to equal the 10 μ A current established by the LM329 reference diode and the 700 k Ω resistor. Since Q1B's collector current cannot vary, its V_{BE} is also fixed. Under these conditions only Q1A's V_{BE} will be affected by the circuit's input. The

circuit's output is a function of:

$$E_{OUT} = \frac{15.7k + 1k}{1k} (V_{BEQ1B} - V_{BEQ1A})$$

For Q1A and Q1B operating at different collector currents, the V_{BE} difference is:

$$\Delta V_{BE} = \frac{KT}{q} \log_e \frac{I_{CQ1A}}{I_{CQ1B}}$$

where K = Boltzman's constant

T = temperature $^{\circ}$ K

q = charge of an electron.

If both equations are combined, the circuit output for a voltage input is:

$$E_{OUT} = \frac{-KT}{9} \frac{15.7k + 1k}{1k} \log_e \frac{E_{IN} \cdot 700k}{6.9V \cdot 100k}$$

where 6.9V = V_Z of LM329

100k = input resistor

$E_{IN} \geq 0$.

This confirms that the circuit output voltage is logarithmically related to the circuit's input. Without some form of compensation, the scale factor will change with temperature. The simplest way to avoid this is to have the 1 k Ω value vary with temperature. For the device shown, compensation is within 1% over -25° C to $+100^{\circ}$ C. The circuit's gain is set by the 15.7 k Ω -1 k Ω divider to a factor of 1V/decade.

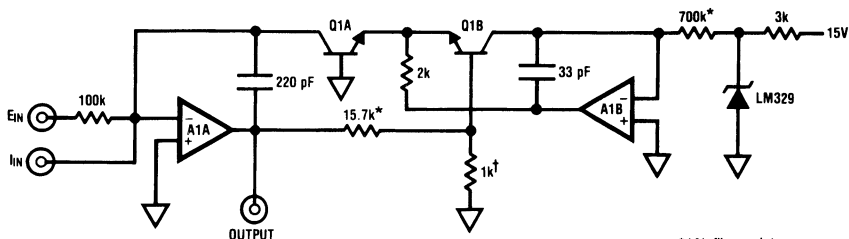


FIGURE 1

*1% film resistor

†Type Q81, Tel Labs

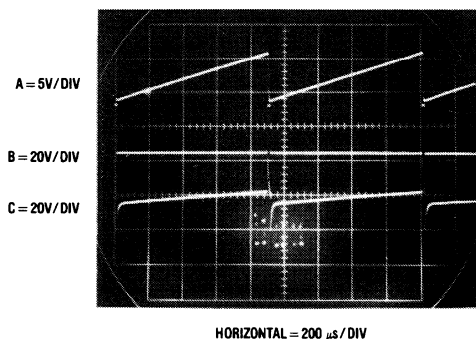
A1A, A1B = LF412 dual

Q1A, Q1B = LM394 dual

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input amplifier A1D. Q1B's collector current, instead of biasing a voltage output amplifier as in *Figure 2*, pulls current from the A1B integrator which ramps up (trace A, *Figure 4*) until it is reset by level triggered A1C (A1C output is trace B, *Figure 4*). The 100 pF capacitor provides AC positive feedback to A3C's "+" input (trace C, *Figure 4*). The magnitude of the current that Q1B's collector pulls from A1B's summing junction will set the frequency of operation of this oscillator. Note that the operation of the exponentiator is similar to the basic circuit in *Figure 3* because A1B's summing junction is always at virtual ground. A1C's output drives the MM74C76 flip-flop to bias the output transistors with 4-phase drive for a stepper motor which runs the pump head. In practice, the exponentiator allows very fine and predictable control for very slow pump rates (e.g., 0.1 rpm-10 rpm of the stepper motor), aiding tight feedback control of the fermentation process. When high pump rates are required, such as during process start-up or when a wide feedback control error exists, the exponentiator can be voltage directed to the top of its range. To calibrate the circuit, ground V_{IN} and adjust the 0.1 Hz trim until oscillation just ceases. Next, apply 7.5V at V_{IN} and adjust the 600 Hz trim for 600 Hz output frequency. *Figure 5* shows a circuit similar to *Figure*

3, except that a more accurate V-F converter is used. This circuit is intended for laboratory and audio studio applications requiring an oscillator whose frequency changes exponentially with an applied input sweep voltage. Applications include swept distortion measurements (where this circuit's output is used to drive a sine coded ROM-DAC combination or analog shaper) and music synthesizers. The V-F converter employed allows better than 0.15% total conformity over a range of 10 Hz-30 kHz. The voltage reference used to drive A1A's input resistor is derived from the LM331A's internal reference and is scaled by A1B, which also biases the zero trim setting. The DM74C74 provides a square wave output for applications requiring a waveform with substantial fundamental frequency content. The 0.15% conformity performance achieved by this circuit will meet almost any synthesizer or swept distortion measurement and the scale factor may be easily varied. To trim, apply 0V to the input and adjust zero until oscillation (typically 2 Hz-3 Hz) just starts. Next, apply -8V and adjust the 5k unit for an output frequency of 30 kHz. For the values given, the K factor of the exponentiator will yield a precise doubling in frequency for each volt of input (e.g., 1V in per octave out).



TL/H/5045-3

FIGURE 4

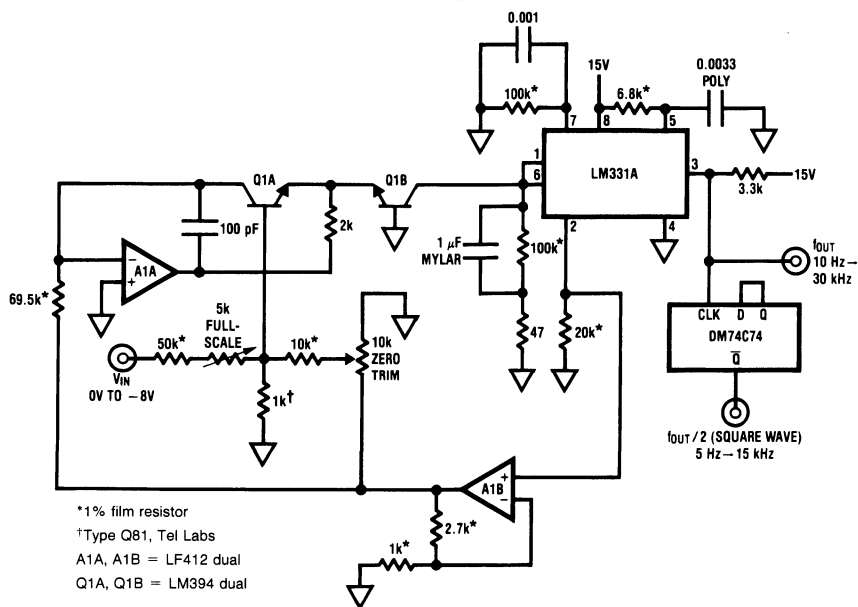
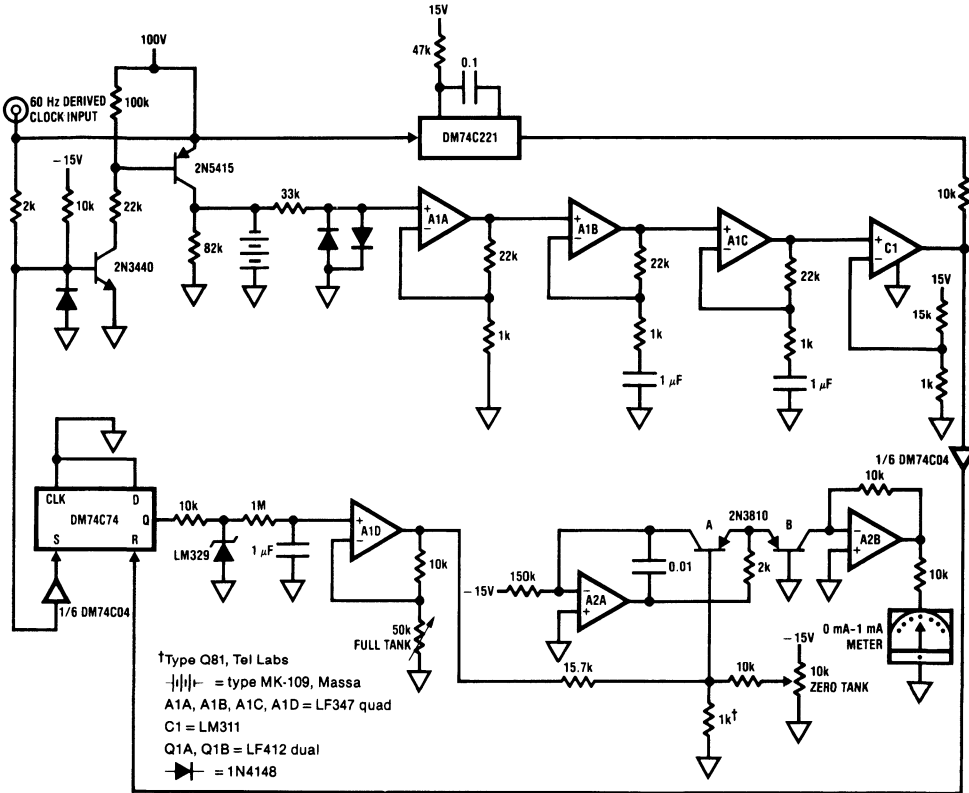


FIGURE 5

TL/H/5045-4

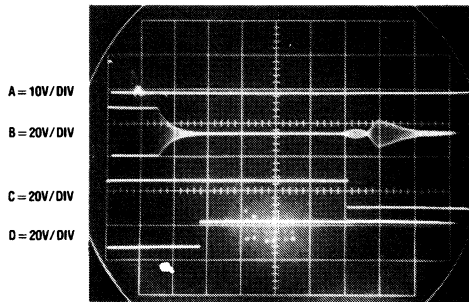
Figure 6 shows a way to use the exponentiator circuit in a non-invasive, high reliability gas gauge which was designed for use in irrigation pump arrangements in remote locations. The application calls for a highly reliable gas gauge to be retrofitted to large fuel tanks which supply pump motors. It is desirable to run the gas tanks down as closely to empty as possible to eliminate condensation build-up without running out of fuel. This acoustically-based scheme operates by bouncing an ultrasonic pulse off the liquid level surface and using the elapsed time to determine the fuel remaining. This time is converted to a voltage, which is exponentiated to provide a readout with high resolution for nearly empty

tanks. The 60 Hz derived clock pulse (trace A, Figure 7) drives the transistor pair to bias the ultrasonic transducer with a 100V pulse. Concurrently, the DM74C74 flip-flop is set high (trace C, Figure 7) and the DM74C221 one-shot (trace D, Figure 7) is used to disable the output of the receiver amplifier. The acoustic pulse bounces off the gasoline's surface and returns to the transducer. By this time, the disable pulse has gone low and the A1A, A1B, A1C and C1 receiver responds (trace B, Figure 7) to the transducer's output. C1's output resets the flip-flop low via the DM74C04 inverter. The width of the 60 Hz flip-flop output pulse represents the transit time and the fuel remaining. This width is



TL/H/5045-5

FIGURE 6



HORIZONTAL = 1 ms/DIV

FIGURE 7

TL/H/5045-6

voltage clamped and integrated at A1D, whose output drives the exponentiator. The 1V/decade scale factor of the exponentiator means that the last 20% of the meter scale corresponds to a tank with only 2% fuel remaining. The first 10% of the meter indicates 80% of the tank's capacity.

The last application determines density by using photometry. In this arrangement, a light source is optically split (*Figure 8*) and the resultant two beams drive light through a sample and an optical density reference. In this case, the optical sample is a grape, and the photometric set-up is used to correlate the optical density of the grape with its ripeness. Two photomultiplier tubes detect the light passed by the sample and the reference. The ratio of the photomultiplier outputs, which may vary over a wide range, is dependent upon the optical density difference of the sample and the reference. The tubes' output feed a log *ratio* amplifier. This configuration dispenses with the fixed current reference normally employed, and substitutes the output of the

reference channel photomultiplier. In this fashion, the log amplifier's output represents the ratio between the densities of the sample and reference channels over a wide dynamic range. Variations in the light source intensity have no effect. Strictly speaking, the LF356 inputs are not at virtual ground, and an imperfect current-to-voltage conversion should result. In fact, the output impedance of the photomultipliers is so high that errors are minimal. The most significant log conformance error source in this simple log circuit is the fact that the transistor's collectors are at slightly different potentials. For the application shown, this uncertainty is not significant.

REFERENCES

Non-Linear Circuits Handbook; Analog Devices, Inc.
Logarithmic Converters, Application Note AN-30;
 R. C. Dobkin; National Semiconductor Corporation.

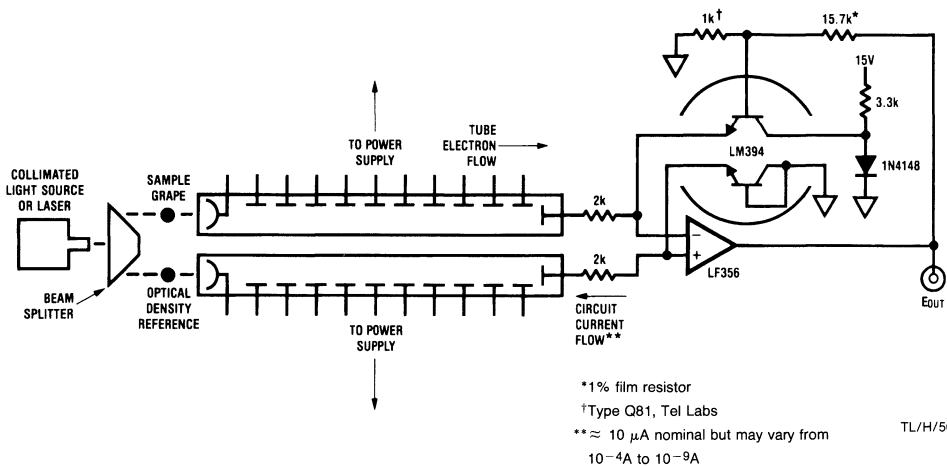


FIGURE 8

Understanding Integrated Circuit Package Power Capabilities

National Semiconductor
Application Note 336
Charles Carinalli
Josip Huljev



INTRODUCTION

The short and long term reliability of National Semiconductor's interface circuits, like any integrated circuit, is very dependent on its environmental condition. Beyond the mechanical/environmental factors, nothing has a greater influence on this reliability than the electrical and thermal stress seen by the integrated circuit. Both of these stress issues are specifically addressed on every interface circuit data sheet, under the headings of Absolute Maximum Ratings and Recommended Operating Conditions.

However, through application calls, it has become clear that electrical stress conditions are generally more understood than the thermal stress conditions. Understanding the importance of electrical stress should never be reduced, but clearly, a higher focus and understanding must be placed on thermal stress. Thermal stress and its application to interface circuits from National Semiconductor is the subject of this application note.

FACTORS AFFECTING DEVICE RELIABILITY

Figure 1 shows the well known "bathtub" curve plotting failure rate versus time. Similar to all system hardware (mechanical or electrical) the reliability of interface integrated circuits conform to this curve. The key issues associated with this curve are infant mortality, failure rate, and useful life.

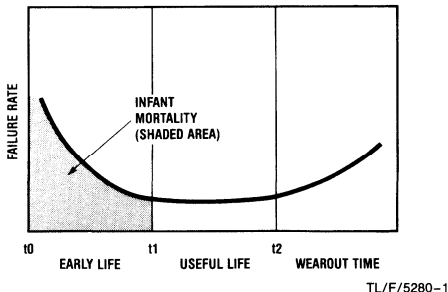


FIGURE 1. Failure Rate vs Time

Infant mortality, the high failure rate from time t_0 to t_1 (early life), is greatly influenced by system stress conditions other than temperature, and can vary widely from one application to another. The main stress factors that contribute to infant mortality are electrical transients and noise, mechanical maltreatment and excessive temperatures. Most of these failures are discovered in device test, burn-in, card assembly and handling, and initial system test and operation. Although important, much literature is available on the subject of infant mortality in integrated circuits and is beyond the scope of this application note.

Failure rate is the number of devices that will be expected to fail in a given period of time (such as, per million hours). The mean time between failure (MTBF) is the average time (in hours) that will be expected to elapse after a unit has failed before the next unit failure will occur. These two primary "units of measure" for device reliability are inversely related:

$$\text{MTBF} = \frac{1}{\text{Failure Rate}}$$

Although the "bathtub" curve plots the overall failure rate versus time, the useful failure rate can be defined as the percentage of devices that fail per-unit-time during the flat portion of the curve. This area, called the useful life, extends between t_1 and t_2 or from the end of infant mortality to the onset of wearout. The useful life may be as short as several years but usually extends for decades if adequate design margins are used in the development of a system.

Many factors influence useful life including: pressure, mechanical stress, thermal cycling, and electrical stress. However, die temperature during the device's useful life plays an equally important role in triggering the onset of wearout.

FAILURE RATES vs TIME AND TEMPERATURE

The relationship between integrated circuit failure rates and time and temperature is a well established fact. The occurrence of these failures is a function which can be represented by the Arrhenius Model. Well validated and predominantly used for accelerated life testing of integrated circuits, the Arrhenius Model assumes the degradation of a performance parameter is linear with time and that MTBF is a function of temperature stress. The temperature dependence is an exponential function that defines the probability of occurrence. This results in a formula for expressing the lifetime or MTBF at a given temperature stress in relation to another MTBF at a different temperature. The ratio of these two MTBFs is called the acceleration factor F and is defined by the following equation:

$$F = \frac{X_1}{X_2} = \exp \left[\frac{E}{K} \left(\frac{1}{T_2} - \frac{1}{T_1} \right) \right]$$

Where: X_1 = Failure rate at junction temperature T_1

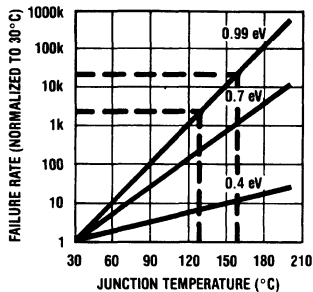
X_2 = Failure rate at junction temperature T_2

T = Junction temperature in degrees Kelvin

E = Thermal activation energy in electron volts (ev)

K = Boltzman's constant

However, the dramatic acceleration effect of junction temperature (chip temperature) on failure rate is illustrated in a plot of the above equation for three different activation energies in *Figure 2*. This graph clearly demonstrates the importance of the relationship of junction temperature to device failure rate. For example, using the 0.99 eV line, a 30° rise in junction temperature, say from 130°C to 160°C, results in a 10 to 1 increase in failure rate.



TL/F/5280-2

FIGURE 2. Failure Rate as a Function of Junction Temperature

DEVICE THERMAL CAPABILITIES

There are many factors which affect the thermal capability of an integrated circuit. To understand these we need to understand the predominant paths for heat to transfer out of the integrated circuit package. This is illustrated by *Figures 3 and 4*.

Figure 3 shows a cross-sectional view of an assembled integrated circuit mounted into a printed circuit board.

Figure 4 is a flow chart showing how the heat generated at the power source, the junctions of the integrated circuit

from the chip to the ultimate heat sink, the ambient environment. There are two predominant paths. The first is from the die to the die attach pad to the surrounding package material to the package lead frame to the printed circuit board and then to the ambient. The second path is from the package directly to the ambient air.

Improving the thermal characteristics of any stage in the flow chart of *Figure 4* will result in an improvement in device thermal characteristics. However, grouping all these characteristics into one equation determining the overall thermal capability of an integrated circuit/package/environmental condition is possible. The equation that expresses this relationship is:

$$T_J = T_A + P_D (\theta_{JA})$$

Where: T_J = Die junction temperature

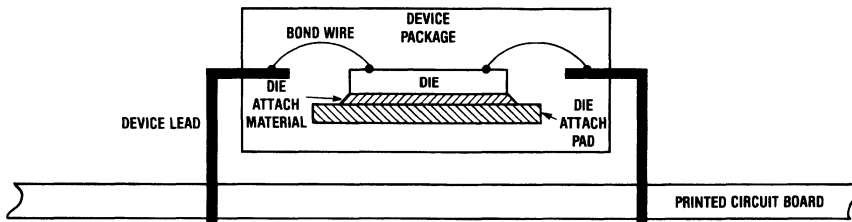
T_A = Ambient temperature in the vicinity device

P_D = Total power dissipation (in watts)

θ_{JA} = Thermal resistance junction-to-ambient

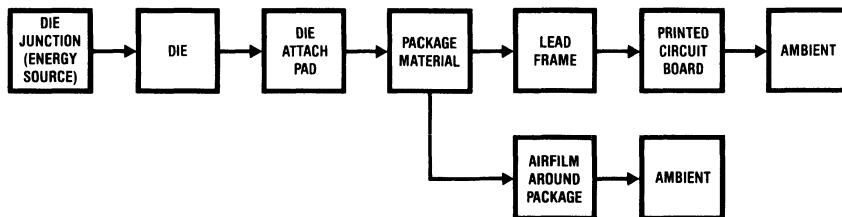
θ_{JA} , the thermal resistance from device junction-to-ambient temperature, is measured and specified by the manufacturers of integrated circuits. National Semiconductor utilizes special vehicles and methods to measure and monitor this parameter. All interface circuit data sheets specify the thermal characteristics and capabilities of the packages available for a given device under specific conditions—these package power ratings directly relate to thermal resistance junction-to-ambient or θ_{JA} .

Although National provides these thermal ratings, it is critical that the end user understand how to use these numbers to improve thermal characteristics in the development of his system using interface components.



TL/F/5280-3

FIGURE 3. Integrated Circuit Soldered into a Printed Circuit Board (Cross-Sectional View)



TL/F/5280-4

FIGURE 4. Thermal Flow (Predominant Paths)

DETERMINING DEVICE OPERATING JUNCTION TEMPERATURE

From the above equation the method of determining actual worst-case device operating junction temperature becomes straightforward. Given a package thermal characteristic, θ_{JA} , worst-case ambient operating temperature, $T_A(\max)$, the only unknown parameter is device power dissipation, P_D . In calculating this parameter, the dissipation of the integrated circuit due to its own supply has to be considered, the dissipation within the package due to the external load must also be added. The power associated with the load in a dynamic (switching) situation must also be considered. For example, the power associated with an inductor or a capacitor in a static versus dynamic (say, 1 MHz) condition is significantly different.

The junction temperature of a device with a total package power of 600 mW at 70°C in a package with a thermal resistance of 63°C/W is 108°C.

$$T_J = 70^\circ\text{C} + (63^\circ\text{C}/\text{W}) \times (0.6\text{W}) = 108^\circ\text{C}$$

The next obvious question is, "how safe is 108°C?"

MAXIMUM ALLOWABLE JUNCTION TEMPERATURES

What is an acceptable maximum operating junction temperature is in itself somewhat of a difficult question to answer. Many companies have established their own standards based on corporate policy. However, the semiconductor industry has developed some defacto standards based on the device package type. These have been well accepted as numbers that relate to reasonable (acceptable) device lifetimes, thus failure rates.

National Semiconductor has adopted these industry-wide standards. For devices fabricated in a molded package, the maximum allowable junction temperature is 150°C. For these devices assembled in ceramic or cavity DIP packages, the maximum allowable junction temperature is 175°C. The numbers are different because of the differences in package types. The thermal strain associated with the die package interface in a cavity package is much less than that exhibited in a molded package where the integrated circuit chip is in direct contact with the package material.

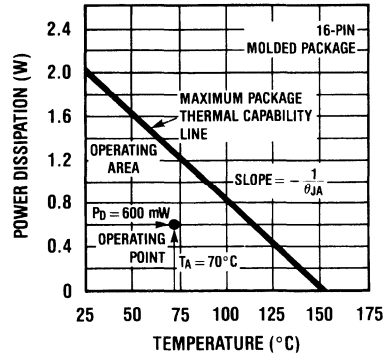
Let us use this new information and our thermal equation to construct a graph which displays the safe thermal (power) operating area for a given package type. Figure 5 is an example of such a graph. The end points of this graph are easily determined. For a 16-pin molded package, the maximum allowable temperature is 150°C; at this point no power dissipation is allowable. The power capability at 25°C is 1.98W as given by the following calculation:

$$P_D @ 25^\circ\text{C} = \frac{T_J(\max) - T_A}{\theta_{JA}} = \frac{150^\circ\text{C} - 25^\circ\text{C}}{63^\circ\text{C}/\text{W}} = 1.98\text{W}$$

The slope of the straight line between these two points is minus the inversion of the thermal resistance. This is referred to as the derating factor.

$$\text{Derating Factor} = -\frac{1}{\theta_{JA}}$$

As mentioned, Figure 5 is a plot of the safe thermal operating area for a device in a 16-pin molded DIP. As long as the intersection of a vertical line defining the maximum ambient temperature (70°C in our previous example) and maximum device package power (600 mW) remains below the maximum package thermal capability line the junction temperature will remain below 150°C—the limit for a molded package. If the intersection of ambient temperature and package power fails on this line, the maximum junction temperature will be 150°C. Any intersection that occurs above this line will result in a junction temperature in excess of 150°C and is not an appropriate operating condition.



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FIGURE 5. Package Power Capability vs Temperature

The thermal capabilities of all interface circuits are expressed as a power capability at 25°C still air environment with a given derating factor. This simply states, for every degree of ambient temperature rise above 25°C, reduce the package power capability stated by the derating factor which is expressed in mW/°C. For our example—a θ_{JA} of 63°C/W relates to a derating factor of 15.9 mW/°C.

FACTORS INFLUENCING PACKAGE THERMAL RESISTANCE

As discussed earlier, improving any portion of the two primary thermal flow paths will result in an improvement in overall thermal resistance junction-to-ambient. This section discusses those components of thermal resistance that can be influenced by the manufacturer of the integrated circuit. It also discusses those factors in the overall thermal resistance that can be impacted by the end user of the integrated circuit. Understanding these issues will go a long way in understanding chip power capabilities and what can be done to insure the best possible operating conditions and, thus, best overall reliability.

Die Size

Figure 6 shows a graph of our 16-pin DIP thermal resistance as a function of integrated circuit die size. Clearly, as the chip size increases the thermal resistance decreases—this relates directly to having a larger area with which to dissipate a given power.

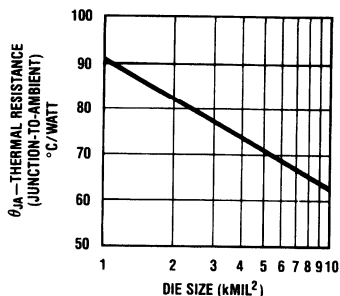


FIGURE 6. Thermal Resistance vs Die Size

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Lead Frame Material

Figure 7 shows the influence of lead frame material (both die attach and device pins) on thermal resistance. This graph compares our same 16-pin DIP with a copper lead frame, a Kovar lead frame, and finally an Alloy 43 type lead frame—these are lead frame materials commonly used in the industry. Obviously the thermal conductivity of the lead frame material has a significant impact in package power capability. Molded interface circuits from National Semiconductor use the copper lead frame exclusively.

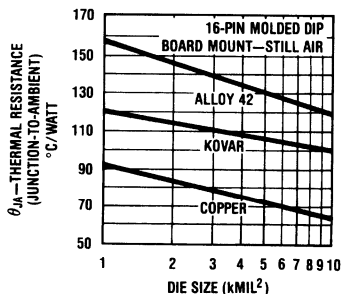


FIGURE 7. Thermal Resistance vs Lead Frame Material

TL/F/5280-7

Board vs Socket Mount

One of the major paths of dissipating energy generated by the integrated circuit is through the device leads. As a result of this, the graph of Figure 8 comes as no surprise. This compares the thermal resistance of our 16-pin package soldered into a printed circuit board (board mount) compared to the same package placed in a socket (socket mount). Adding a socket in the path between the PC board and the device adds another stage in the thermal flow path, thus increasing the overall thermal resistance. The thermal capabilities of National Semiconductor's interface circuits are specified assuming board mount conditions. If the devices are placed in a socket the thermal capabilities should be reduced by approximately 5% to 10%.

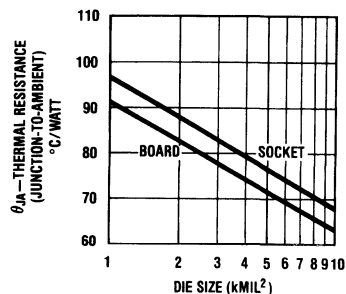


FIGURE 8. Thermal Resistance vs Board or Socket Mount

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Air Flow

When a high power situation exists and the ambient temperature cannot be reduced, the next best thing is to provide air flow in the vicinity of the package. The graph of Figure 9 illustrates the impact this has on thermal resistance. This graph plots the relative reduction in thermal resistance normalized to the still air condition for our 16-pin molded DIP. The thermal ratings on National Semiconductor's interface circuits data sheets relate to the still air environment.

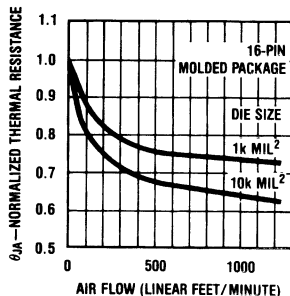


FIGURE 9. Thermal Resistance vs Air Flow

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Other Factors

A number of other factors influence thermal resistance. The most important of these is using thermal epoxy in mounting ICs to the PC board and heat sinks. Generally these techniques are required only in the very highest of power applications.

Some confusion exists between the difference in thermal resistance junction-to-ambient (θ_{JA}) and thermal resistance junction-to-case (θ_{JC}). The best measure of actual junction temperature is the junction-to-ambient number since nearly all systems operate in an open air environment. The only situation where thermal resistance junction-to-case is important is when the entire system is immersed in a thermal bath and the environmental temperature is indeed the case temperature. This is only used in extreme cases and is the exception to the rule and, for this reason, is not addressed in this application note.

NATIONAL SEMICONDUCTOR PACKAGE CAPABILITIES

Figures 10 and 11 show composite plots of the thermal characteristics of the most common package types in the National Semiconductor Interface Circuits product family. Figure 10 is a composite of the copper lead frame molded package. Figure 11 is a composite of the ceramic (cavity) DIP using poly die attach. These graphs represent board mount still air thermal capabilities. Another, and final, thermal resistance trend will be noticed in these graphs. As the number of device pins increase in a DIP the thermal resistance decreases. Referring back to the thermal flow chart, this trend should, by now, be obvious.

RATINGS ON INTERFACE CIRCUITS DATA SHEETS

In conclusion, all National Semiconductor Interface Products define power dissipation (thermal) capability. This information can be found in the Absolute Maximum Ratings section of the data sheet. The thermal information shown in this application note represents average data for characterization of the indicated package. Actual thermal resistance can vary from ±10% to ±15% due to fluctuations in assembly quality, die shape, die thickness, distribution of heat sources on the die, etc. The numbers quoted in the interface data sheets reflect a 15% safety margin from the average num-

bers found in this application note. Insuring that total package power remains under a specified level will guarantee that the maximum junction temperature will not exceed the package maximum.

The package power ratings are specified as a maximum power at 25°C ambient with an associated derating factor for ambient temperatures above 25°C. It is easy to determine the power capability at an elevated temperature. The power specified at 25°C should be reduced by the derating factor for every degree of ambient temperature above 25°C. For example, in a given product data sheet the following will be found:

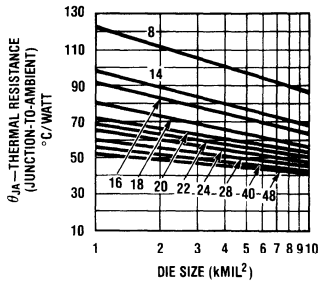
Maximum Power Dissipation* at 25°C	
Cavity Package	1509 mW
Molded Package	1476 mW

* Derate cavity package at 10 mW/°C above 25°C; derate molded package at 11.8 mW/°C above 25°C.

If the molded package is used at a maximum ambient temperature of 70°C, the package power capability is 945 mW.

$$P_D @ 70^\circ\text{C} = 1476 \text{ mW} - (11.8 \text{ mW}/^\circ\text{C}) \times (70^\circ\text{C} - 25^\circ\text{C}) = 945 \text{ mW}$$

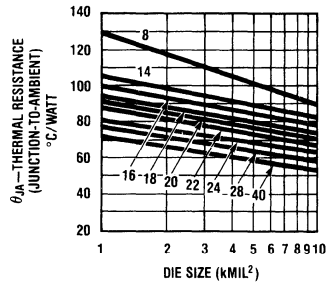
**Molded (N Package) DIP*
Copper Leadframe—HTP
Die Attach Board Mount—
Still Air**



*Packages from 8- to 20-pin 0.3 mil width
22-pin 0.4 mil width
24- to 40-pin 0.6 mil width
TL/F/5280-10

FIGURE 10. Thermal Resistance vs Die Size vs Package Type (Molded Package)

**Cavity (J Package) DIP*
Poly Die Attach Board
Mount—Still Air**



*Packages from 8- to 20-pin 0.3 mil width
22-pin 0.4 mil width
24- to 48-pin 0.6 mil width
TL/F/5280-11

FIGURE 11. Thermal Resistance vs Die Size vs Package Type (Cavity Package)

LH1605 Switching Regulator

National Semiconductor
Application Note 343



AN-343

INTRODUCTION

The LH1605 is the first in a family of high-efficiency switching regulators designed to simplify power conversion while minimizing power losses. It can deliver 5 amps continuous output current and operate over a wide range of input and output voltages. In classic step-down voltage regulator applications it requires only 4 external parts: a resistor, 2 capacitors and an inductor. The device is housed in a standard 8-pin TO-3 power package containing a temperature compensated voltage reference, an error amplifier, a pulse-width modulator with programmable operating frequency and a high current output switch and steering diode. Typical performance of the LH1605 is summarized in Table I.

This discussion details LH1605 operating theory and analyzes device power considerations. It also explains DC/DC conversion using the LH1605 and presents design criteria and examples. A section suggesting other typical LH1605 applications is included, as in an appendix listing suppliers of capacitors, magnetic components and heat sinks suitable for use with the LH1605.

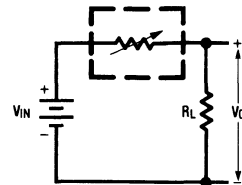
TABLE I. LH1605 Typical Performance Characteristics

	Parameter	Value
I_O	Continuous Output Current	5A
V_{IN}	Input Voltage	10V-35V
V_O	Output Voltage	3V-30V
V_S	Switch Saturation Voltage, $I_{OUT} = 4A$	1.4V
ΔV_R	Line Regulation of Reference Voltage	20 mV
η	Efficiency	70%
θ_{JC}	Thermal Resistance	5°C/W

THEORY OF OPERATION

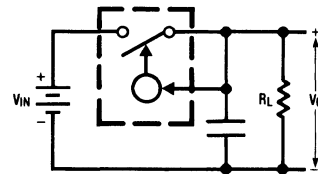
Unlike linear regulators, which rely on a linear series element to control the flow of power to a load, switching regulators utilize a series switch which is either open or closed (*Figure 1*). Average output voltage is proportional to the ratio of switch closed time to switch open time, expressed as the switch duty cycle.

$$D = \frac{t_{ON}}{t_{ON} + t_{OFF}} \quad (1)$$



TL/K/5496-1

FIGURE 1a. Linear Regulator



TL/K/5496-2

FIGURE 1b. Switching Regulator

A switching regulator achieves a constant average output by varying the switch duty cycle according to output feedback.

In the LH1605 (*Figure 2*), a pulse-width modulator operating at a frequency determined by an external capacitor, C_T , varies the duty cycle of a Darlington transistor switch according to the feedback voltage applied to pin 3.

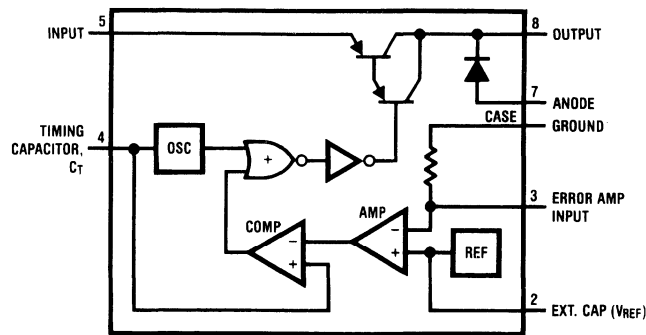
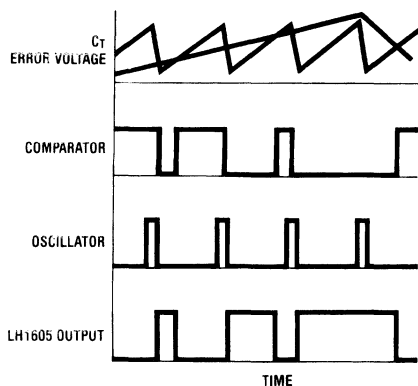


FIGURE 2. Block Diagram of the LH1605

TL/K/5496-3

To achieve precise regulation, the difference between the feedback voltage and the internal reference is amplified, creating an error voltage which varies inversely with the feedback signal. This error voltage is compared to a periodic ramp voltage created across C_T by a constant current source within the oscillator. Comparator output is low until the ramp voltage exceeds the error voltage. *Figure 3* illustrates how fluctuations in error voltage alter the duty cycle of the comparator's output.

The comparator output is logically combined with a blanking pulse created by the oscillator while discharging C_T . This produces a constant frequency switch drive signal whose leading edge coincides with the falling edge of the blanking pulse. Note that, because the oscillator blanking pulse is shorter than the combined delay time of the drive signal buffer and the switch transistors, the LH1605 can run at 100% duty cycle for sufficiently low feedback voltage on pin 3.



TL/K/5496-4

FIGURE 3. LH1605 Timing Diagram

EFFICIENCY CALCULATIONS

Because high-efficiency is the principle advantage of switched-mode power conversion, switching regulator losses are an important design concern. Losses and efficiency of the LH1605 can be calculated with the following equations. (Note: pin 7 is grounded; I_O = average current output at pin 8.)

$$\text{Switching Period (T)} = \frac{1}{f_o} = t_{ON} + t_{OFF} \quad (2)$$

$$\text{Duty Cycle (D)} = \frac{t_{ON}}{t_{ON} + t_{OFF}} = \frac{V_O + V_F}{V_{IN} - V_S + V_F} \quad (3)$$

$$\text{Transistor DC Losses (P}_T) = V_S \times I_O \times D \quad (4)$$

$$\text{Transistor Switching Losses (P}_S) = (V_{IN} + V_F) \times I_O \times \frac{(t_r + t_f + 2t_s) f_o}{2} \quad (5)$$

$$\text{Diode DC Losses (P}_D) = V_F \times I_O \times (1 - D) \quad (6)$$

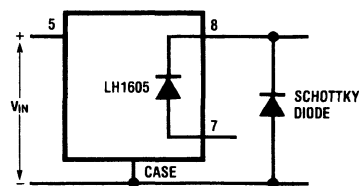
$$\text{Drive Circuit Losses (D}_L) = \frac{V_{IN}^2}{300} \times D \quad (7)$$

$$\text{Power Output (P}_O) = \frac{(V_{IN} - V_S) t_{ON} - (V_F) t_{OFF}}{t_{ON} + t_{OFF}} \times I_O \quad (8)$$

$$\text{Efficiency } (\eta) = \frac{P_O}{P_{IN}} = \frac{P_O}{P_O + P_T + P_S + P_D + D_L} \quad (9)$$

As with all switching regulators, the LH1605 requires some external filter to achieve a non-pulsating output. The overall circuit efficiency, therefore, must include power losses in the filter section (discussed later) as well as losses in the LH1605.

From equation 5, it follows that LH1605 efficiency is improved as the operating frequency is reduced. Efficiency can also be improved by adding an external Schottky diode with the LH1605's as shown in *Figure 4*. Schottky diodes exhibit almost no storage time and have a very low forward voltage drop. When using an external Schottky diode, the steering diode at pin 7 should be left open to insure that it contributes no storage delay losses.



TL/K/5496-5

FIGURE 4. LH1605 with External Schottky Diode

HEAT SINKING CONSIDERATIONS

Even at moderate output power, there is significant self-heating of the LH1605 due to internal power dissipation. To prevent thermal damage, the junction temperature, T_j , must remain below 150°C under all operating conditions. Some useful expressions for steady state thermal design are given below:

$$P_{DISS} = \frac{P_O - \eta P_O}{\eta} < \frac{T_{J(MAX)} - T_{A(MAX)}}{\theta_{JC} + \theta_{CS} + \theta_{SA}} \quad (10)$$

$$\theta_{CS} + \theta_{SA} < \frac{T_{J(MAX)} - T_{A(MAX)}}{P_{DISS}} - \theta_{JC} \quad (11)$$

Where:

$T_{J(MAX)}$ = maximum allowable junction temperature, 175°C.

$T_{A(MAX)}$ = Maximum ambient operating temperature in °C.

θ_{JC} = device junction-to-case thermal resistance, typically 5°C/W.

θ_{CS} = case-to-heat sink thermal resistance in °C/W.

θ_{SA} = heat sink-to-ambient thermal resistance in °C/W.

The case-to-heat sink thermal resistance depends on the interface materials used. The following list gives the expected values for various materials.

0.002" thick insulating mica	
without thermal grease	1.20°C/W
with thermal grease	0.35°C/W

0.003" thick insulating mica	
without thermal grease	1.30°C/W
with thermal grease	0.38°C/W
Bare joint	
without thermal grease	0.50°C/W
with thermal grease	0.15°C/W

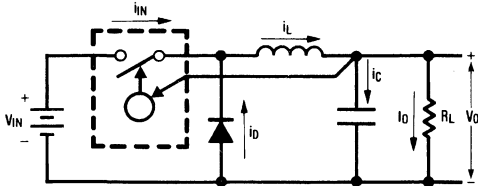
Most heat sink manufacturers provide the heat sink-to-ambient thermal resistance under convection as well as forced-air cooling. Appendix A gives a partial list of hardware and manufacturers.

DC/DC CONVERSION

The LH1605 operates only in Buck-type DC/DC converters. A Buck converter produces a positive DC output voltage which is less than its input voltage. It consists of a switching regulator, a steering diode, an inductor and a capacitor (Figure 5). During the switch ON time, inductor current, i_L , builds, flowing to both the capacitor and the load. During t_{OFF} , the magnetic energy stored in the inductor draws current through the diode. The capacitor serves to filter the output voltage by sourcing current while i_L is low and sinking current when i_L is high.

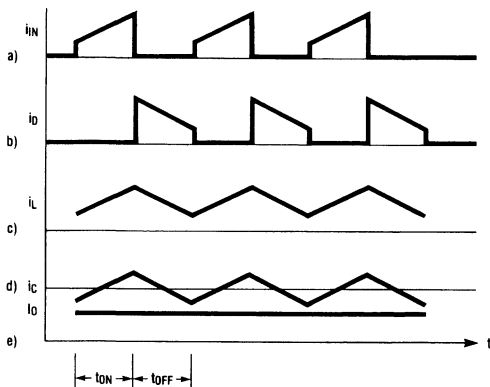
Figure 6 illustrates the current waveforms of the paths labeled in Figure 5.

As the load increases, more current must be supplied to maintain a given output voltage. The switching regulator senses the drop in V_O and increases switch duty cycle to raise the average i_L . Likewise, a reduction in loading causes a reduction in switch duty cycle.



TL/K/5496-6

FIGURE 5. Buck-Type Step-Down Voltage Converter



TL/K/5496-7

FIGURE 6. Buck Converter Current Waveforms

INDUCTOR DESIGN

The primary function of the inductor in a switching converter is to reduce the ripple current flowing to the output node. Inductor current, Figure 6c, consists of a DC value equal to the average converter output current, I_O , and a ripple current whose peak-to-peak value is:

$$\Delta I_L = \frac{(V_{IN} - V_O)}{L} \times t_{ON} \quad (12)$$

If ΔI_L is greater than $2I_O$, i_L will become zero for a portion of each switching cycle (Figure 7), which may result in an unstable output voltage.

To maintain $i_L > 0$, L must be made large enough so that:

$$I_{O(MIN)} > \frac{[V_{IN(MAX)} - V_O]}{2L} \times t_{ON} \quad (13)$$

Equation 14 conveniently expresses the minimum required inductance as a function of $I_{O(MIN)}$ and the operating frequency, f_o .

$$L > [V_{IN(MAX)} - V_O] \left(\frac{V_O}{V_{IN(MAX)}} \right) \times \frac{1}{2f_o} \times \frac{1}{I_{O(MIN)}} \quad (14)$$

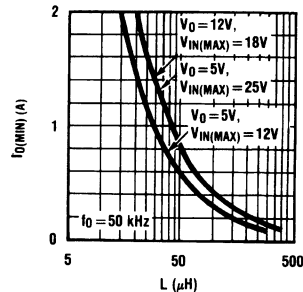
The graph in Figure 8 plots L vs $I_{O(MIN)}$ for some common converter parameters.

The next consideration for inductor design is the choice of an appropriate magnetic core. The core must provide the desired inductance without saturating under maximum output conditions. Magnetic core saturation leads to excessive inductor current which jeopardizes output stability and may damage both the switching regulator and the load circuitry it supplies.



TL/K/5496-8

FIGURE 7. Inductor Current with $\Delta I_L > 2I_O$



TL/K/5496-9

FIGURE 8. Inductance vs Minimum Output Current

Switching converter inductor cores are normally made of ferrite or molypermalloy powder to minimize core loss at high switching frequencies. The core should provide a closed flux path to minimize radiated noise due to flux leakage. Toroidal and fully enclosed pot cores are popular for this reason.

To further reduce flux leakage, the core winding should be a single layer covering a maximum amount of the winding surface. The number of winding turns necessary for an inductance, L, is:

$$N = 1000 \times \sqrt{\frac{L}{L_{1000}}} \quad (15)$$

Core manufacturers specify the nominal inductance, L₁₀₀₀ mH per 1000 turns, for a given core as well as the maximum magnetic energy, LI², that a core can sustain without saturation. LI² is calculated using L as determined by equation 14 and I equal to the maximum anticipated output current plus I_{O(MIN)}.

When using a core with optimum magnetic performance at the desired switching frequency, the I²R loss in the winding will dominate inductor power losses. This loss,

$$P_L = I_O^2 \times R_L \text{ (DC winding resistance)} \quad (16)$$

can be reduced by using large diameter copper wire for the core winding.

Many magnetic core manufacturers offer further information on inductor design. Some companies now specialize in supplying pre-wound inductors to meet specific switching converter needs. A partial list of core manufacturers and inductor suppliers is included in Appendix A.

CHOOSING AN OUTPUT CAPACITOR

The output filter capacitor reduces the peak-to-peak output ripple voltage, e_O, by integrating the inductor ripple current at the output node. To do this, the capacitor may have to source and sink currents as high as 2A. At these current levels, the drop across the capacitor's effective series resistance, ESR, could dominate e_O. Figure 9 shows an example where no amount of capacitance could achieve less than 50 mV output ripple.

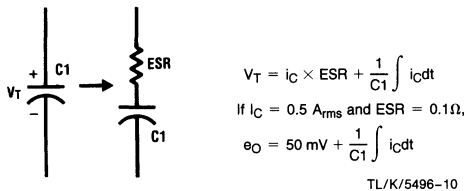


FIGURE 9. Effect of ESR on e_O

Because the ESR of a large capacitor is generally less than that of a small capacitor of similar construction, the easiest way to reduce ESR is to use a large capacitor. ESR can also be reduced by using 2 or more capacitors in parallel. Capacitor leads and the PC board traces connecting them contrib-

ute to the ESR and should be made as short as possible. To reduce output voltage spikes due to switching transients, a 0.1 μF ceramic capacitor should be used in parallel with an electrolytic capacitor. A partial list of manufacturers of low ESR capacitors is included in Appendix A.

Equation 17 is a convenient expression for determining the minimum required capacitance as a function of e_O, f_O, ESR, and the inductor ripple current.

$$C > \frac{I_O(MIN)}{4f_O} \times \frac{1}{e_O - (I_O(MIN) \times ESR)} \quad (17)$$

Figure 10 plots C vs e_O for some common converter parameters.

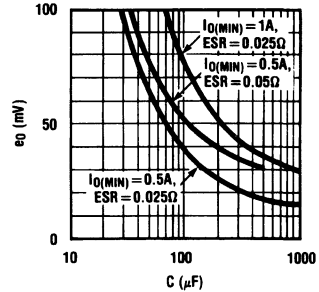


FIGURE 10. Capacitance vs Output Ripple Voltage

Power loss in a filter capacitor is almost entirely due to ESR. This loss is given by:

$$P_C = \left(\frac{I_O(MIN)}{2}\right)^2 \times ESR \quad (18)$$

FEEDBACK

The LH1605 regulates output voltage using a single feedback resistor. The resistor, R_f, forms a voltage divider with a 2 kΩ internal resistor from pin 3 of the LH1605 to ground (Figure 11). A steady state output voltage is reached when the voltage on pin 3 is approximately equal to the reference voltage on pin 2, about 2.5V.

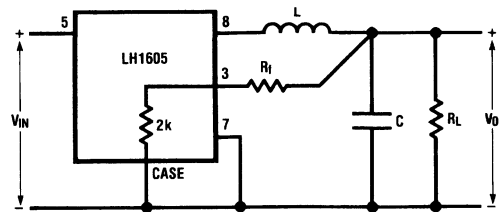
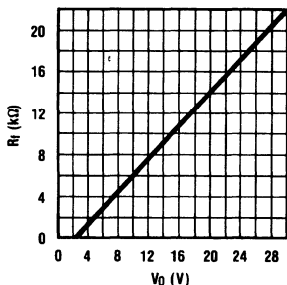


FIGURE 11. Output Voltage Feedback with LH1605

The output voltage can be programmed by selecting a feedback resistor as follows:

$$R_f = 2 \text{ k}\Omega \frac{V_{\text{OUT}} - 2.5\text{V}}{2.5\text{V}} \quad (19)$$

Figure 12 shows the linear relationship between R_f and V_o .



TL/K/5496-13

FIGURE 12. Feedback Resistance vs Output Voltage

CURRENT LIMITING

LH1605 current limiting is best done by pulling down the reference voltage at pin 2. This reduces the output pulse-width on a cycle-to-cycle basis. Clamping the reference to ground inhibits the output switch and can be done with any general purpose transistor.

A 10 μF capacitor from pin 2 to ground will allow the LH1605 to recover with a soft start from an over-current condition. Figure 13 illustrates a typical current limit circuit for the LH1605 requiring only two transistors and three resistors.

Although this circuit is effective, it has several shortcomings. The $-2.2 \text{ mV}/^\circ\text{C}$ TC of Q1 can cause a 34% drift in the current limit set point over the -25°C to $+85^\circ\text{C}$ temperature range, and the relatively large R_S can decrease overall converter efficiency by as much as 10%. Furthermore, a short circuit condition draws significant power from the input supply. Superior performance can be obtained from a fold-back current limit with only a slightly higher parts count.

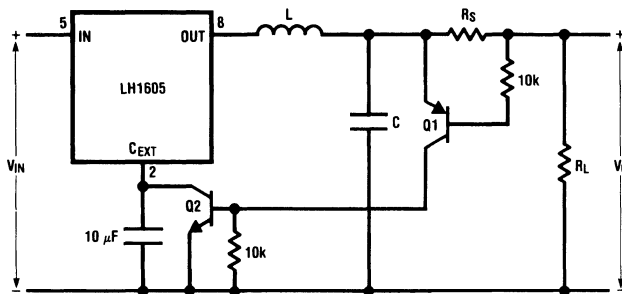
FOLDBACK CURRENT LIMITING

A foldback current limit reduces the current limit threshold as the converter's load increases from an initial overcurrent condition to a complete short circuit. Because short circuit current, I_{SC} , is much less than the initial current limit set point, I_{CL} , a prolonged short circuit draws very little power from the input supply.

In the circuit of Figure 14, initial current limit is reached when the output of Q2 reaches 0.6V, $V_{\text{BE(ON)}}$ of Q1.

This corresponds to $V_{\text{CL}} = \frac{0.6\text{V}}{A_v}$ where

$$A_v = \frac{R_2}{R_1}, R_1 = R_3, R_2 = R_4. \quad (20)$$

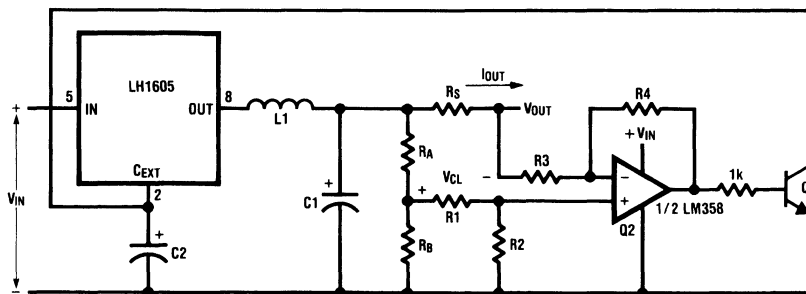


$$I_{\text{CL}} = \frac{0.6\text{V}}{R_S}$$

$$I_{\text{SC}} = \frac{0.75\text{V}}{R_S}$$

TL/K/5496-14

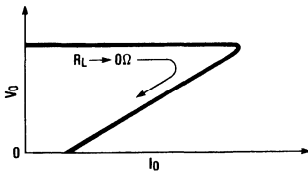
FIGURE 13. Hard Limiting Circuit for LH1605



TL/K/5496-15

FIGURE 14. Foldback Limiting for LH1605

V_{CL} is the sum of the voltage drop across R_S and the opposing drop across R_A . As current limit is reached, V_O is reduced, lowering the voltage across R_A . It then requires less current through R_S to create a V_{CL} sufficient to cause further current limiting. This action produces the I-V characteristics shown in Figure 15. As the overload is removed, the converter output recovers along the same curve.



TL/K/5496-16

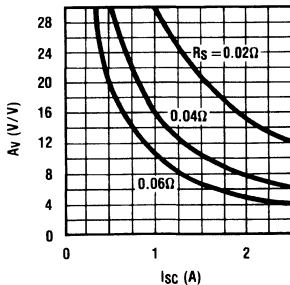
FIGURE 15. V_O vs I_O with Foldback Limiting

Because the gain of Q2 can be quite large, generally 10 to 20, the sense resistor, R_S , can be made very small, 0.02 Ω to 0.06 Ω . This significantly improves overall converter efficiency. Another advantage of amplifier gain is increased temperature stability. A gain of 10 reduces I_{CL} drift to about -3.3 mA/ $^{\circ}$ C with $R_S = 0.06\Omega$.

The first step in designing a foldback current limit for the LH1605 is to choose a readily available value for R_S . Then the amplifier gain can be determined as a function of R_S and the desired short circuit current.

$$A_V = \frac{0.6}{I_{SC} \times R_S} \quad (21)$$

The relationship between A_V , I_{SC} , and R_S is shown in Figure 16. A small capacitor in parallel with R2 and/or R4 may be necessary with high amplifier gains to filter switching noise.



TL/K/5496-17

FIGURE 16. Amplifier Gain vs Short Circuit Current and R_S

The resistors R_A and R_B can be found in terms of V_O , R_S , and the amount of current foldback desired.

$$R_A = \frac{R_B \times R_S}{V_O} (I_{CL} - I_{SC}) \quad (22)$$

The condition $R_B \ll R_1$ should be maintained to insure accuracy in setting I_{CL} . Typical values for these resistors are:

$$1 \text{ k}\Omega < R_B < 5 \text{ k}\Omega$$

$$20 \text{ k}\Omega < R_1 < 100 \text{ k}\Omega$$

Power loss due to the current limit circuit under normal converter operation is:

$$P_{CL} = I_O^2 \times R_S \quad (23)$$

Power drained from the input supply with the converter output short circuited cannot be easily expressed due to the nature of the LH1605's control loop while in current limit. The drain, however, can be minimized by using a foldback current limit with a low I_{SC} .

Design Example

Design requirements:

$$\begin{aligned} V_{IN(MAX)} &= 20V \\ V_{IN(MIN)} &= 10V \\ V_{IN(NOM)} &= 14V \\ V_O &= 5V \\ e_O &= 50 \text{ mV} \\ I_{CL} &= 5A \\ I_O(MIN) &= 0.5A \\ I_{SC} &= 1A \\ f_O &= 25 \text{ kHz} \end{aligned}$$

Inductor

From equation 14:

$$\begin{aligned} L_{MIN} &= (20V - 5V) \left(\frac{5V}{(20V)} \right) \left(\frac{1}{2} \right) \left(\frac{1}{25 \text{ kHz}} \right) \left(\frac{1}{0.5A} \right) \\ &= 150 \mu\text{H}. \end{aligned}$$

The maximum magnetic energy will be:

$$E_L = (150 \mu\text{H}) (5A + 0.5A)^2 = 4.54 \text{ mJ}.$$

A toroidal powdered-iron core from Arnold Engineering, part # SG-0800-0320-T, was chosen for this example because of its high flux density capability. At only 25 kHz switching frequency, a powdered-iron core has very little hysteresis power loss and costs far less than a molypermalloy powder core of comparable flux density capability.

The nominal inductance of this core is 32 mH per 1000 turns. The number of turns required for this design is found using equation 15:

$$N = 1000 \times \sqrt{\frac{150 \mu\text{H}}{32 \text{ mH}}} = 69 \text{ turns}$$

A single layer winding of this core requires about 5.1 feet of #24 wire which would yield a DC winding resistance of 0.13 Ω . In this case, efficiency can be improved significantly by using a double layer winding of #20 wire with only 0.050 Ω .

Capacitor

From equation 17:

$$\begin{aligned} C_{MIN} &= \left(\frac{0.5A}{4} \right) \left(\frac{1}{25 \text{ kHz}} \right) \left(\frac{1}{(0.05V - (0.5A \times \text{ESR}) V)} \right) \\ &= \frac{5}{0.05 - 0.5 \text{ ESR}} \mu\text{F} \end{aligned}$$

Since no capacitor will meet the needs of this application with $\text{ESR} > 0.1\Omega$ at 25 kHz, it is easier in this case to search for a capacitor on the basis of ESR rather than capacitance. Mepco/Electra part #3475GD681M6P3JMBS has a typical ESR at 25 kHz of about 0.06 Ω .

For $\text{ESR} = 0.06\Omega$,

$$C_{MIN} = 250 \mu\text{F}.$$

This part, rated at 680 μF , 6.3 WV_{DC}, is more than adequate for this application.

Feedback

From equation 19:

$$R_f = 2 \text{ k}\Omega \frac{5V - 2.5V}{2.5V} = 2 \text{ k}\Omega.$$

Current Limit

$R_S = 0.05\Omega$, 1.5W will be used in this application.

From equations 21 and 22:

$$A_V = \frac{0.6V}{1A \times 0.05\Omega} = 12,$$

$$R_A = R_B \left(\frac{0.05\Omega}{5V} \right) (5A - 1A) = 0.04 R_B.$$

If $R_B = 2 \text{ k}\Omega$ and $R1 = 100 \text{ k}\Omega$, then,

$$R_A = 80\Omega,$$

$$R2 = R4 = 1.2 \text{ M}\Omega,$$

$$R3 = 100 \text{ k}\Omega.$$

Operating Frequency

From the LH1605 data sheet graph of C_T vs f_O , the desired timing capacitor is,

$$C_T = 0.001 \mu\text{F}.$$

Input Capacitor

The choice of this capacitor depends upon the source impedance and ripple voltage requirements of the input supply. In most applications,

$$C_{IN} > 50 \mu\text{F}$$

The complete circuit is shown in Figure 17.

Using LH1605 data sheet information and equations 2-9 of this note, LH1605 efficiency in this design with $V_{IN} = 14V$ and $I_O = 3A$ is,

$$\eta = \frac{15}{15 + 1.66 + 2.34 + 2.59 + 0.30} = 0.69$$

Equation 11 gives the maximum allowable thermal resistance of heat sink bolted directly to the LH1605 with thermal grease at 50°C ambient temperature:

$$\theta_{SA} = \frac{(150^\circ\text{C} - 50^\circ\text{C})}{6.89W} - 5^\circ\text{C/W} - 0.15^\circ\text{C/W} = 9.4^\circ\text{C/W}$$

By including the power losses found in equations 16, 18 and 23, equation 9 yields the overall converter efficiency:

$$\eta = \frac{15}{21.89 + 0.45 + 0.004 + 0.45} = 0.66$$

So, in this design example, the converter dissipates only 7.8W, whereas a linear regulator under identical input/output conditions would dissipate 27W.

TYPICAL APPLICATIONS

Figure 18 shows a typical LH1605 Buck regulator application powered from the rectified output of a step-down transformer. Because LH1605 regulation is more efficient than equivalent linear regulation, the size and power rating of the transformer and bridge rectifier can be much smaller. Table II contains component values for several converters with this topology.

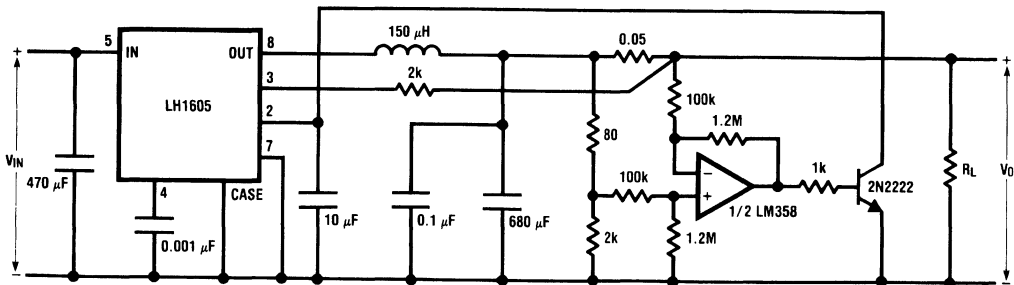


FIGURE 17. Complete Buck Converter Using LH1605

TL/K/5496-18

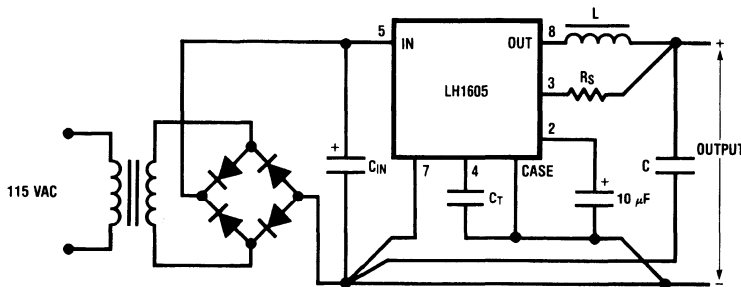


FIGURE 18. Typical Power Supply System

TL/K/5496-19

TABLE II. Typical Component Values for Buck Regulators

f _O = kHz e _O = 50 mV			I _O (MIN)				R _f (Ω)
			1.0A		0.5A		
ESR _C (Ω)	V _{IN} (MAX) (V)	V _O (V)	L _{MIN} (μH)	C _{MIN} (μF)	L _{MIN} (μH)	C _{MIN} (μF)	
0.02	12	5	59	334	117	125	2k
0.03	15	5	67	500	134	143	2k
0.04	25	12	125	1000	250	167	7.6k
0.05	35	24	151	—	302	200	17.2k

Power Distribution Pre-Regulator

In applications requiring very low output ripple voltage, the LH1605 can be used as a pre-regulator to improve system performance and efficiency (Figure 19). By pre-regulating the input to the linear regulators to 5.8V, line frequency ripple is virtually eliminated from the 5V output. The 25 kHz switching ripple is attenuated 70 dB by the LM2931's giving less than 1 mV total output noise voltage.

DC Motor Speed Controller

Figure 20 shows how an LH1605 can be connected as a fractional-horsepower, DC motor speed controller. The constant average output voltage of the LH1605 is set with a single resistor, R_f, as it is in Buck converter applications. Current limiting may be required to protect the LH1605 during start-up of motors with low armature resistance.

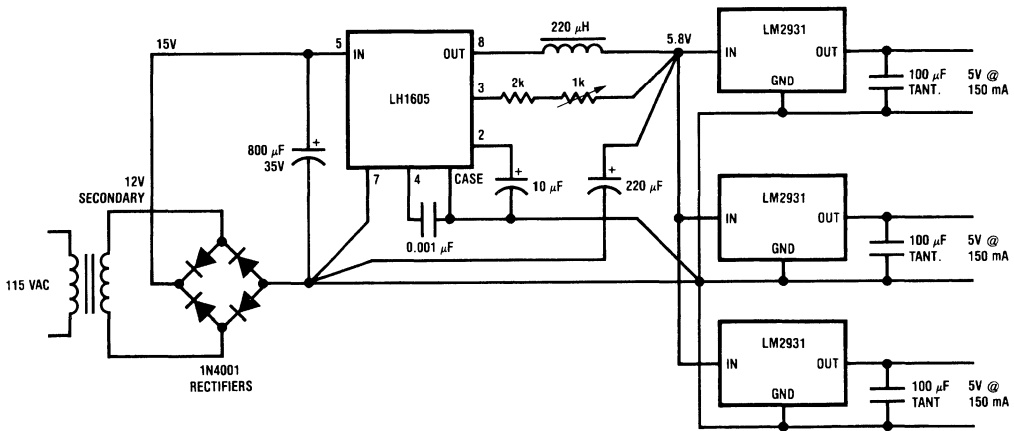


FIGURE 19. Pre-Regulator Power Distribution System

TL/K/5496-20

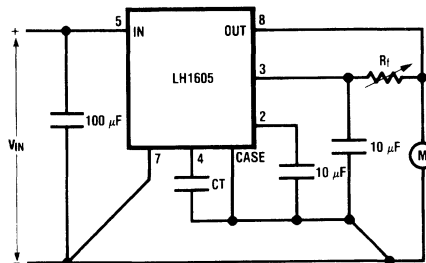


FIGURE 20. DC Motor Speed Regulation

TL/K/5496-21

Multiple Outputs

It is possible, as *Figure 21* suggests, to obtain any number of outputs from a single LH1605 provided there is one primary output in a Buck configuration drawing sufficient output current. During t_{OFF} , the voltage across the primary inductance is $(V_O + V_f)$. The voltage across any secondary windings wound on the same core is $N_S/N_P (V_O + V_f)$. Because V_O is regulated and V_f is nearly constant, the voltages on the secondaries are also constant.

During t_{ON} , the diodes in the secondaries are reverse biased so all secondary power comes from the filter capacitors, C1 and C2. During t_{OFF} , the diodes conduct, and the capacitors are recharged. To ensure stable output voltages,

the Buck converter's output power must be greater than that of the secondaries. In the circuit of *Figure 21*, $I_O \geq 0.8A$ in the 5V primary is necessary in order to have 100 mA capability in the $\pm 12V$ secondaries.

REFERENCES

1. National Semiconductor, 1982 Hybrid Products Data-book.
2. National Semiconductor, "LH1605 5 Amp, High Efficiency Switching Regulator" datasheet.
3. Abraham I. Pressman, "Switching and Linear Power Supply, Power Converter Design", Hyden Book Company, 1977.

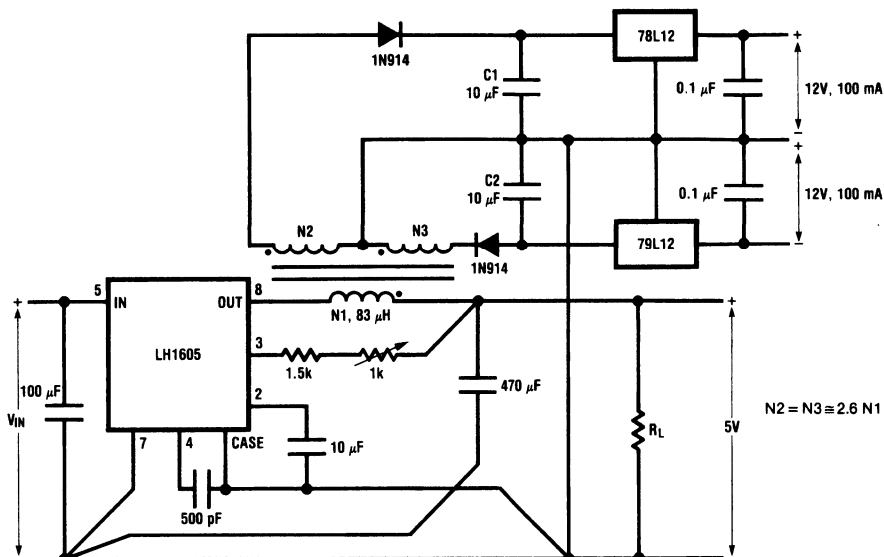


FIGURE 21. Multiple Output Voltages from a Single LH1605

TL/K/5496-22

APPENDIX A

Following is a partial list of sockets, heat dissipators, magnetic components and low ESR-type capacitors for use with the LH1605. National Semiconductor Corporation assumes no responsibility for their quality or availability.

8-LEAD TO-3 HARDWARE**Sockets**

Robinson Nugent 0002011
Azimuth 6028 (test socket)

AAVID ENGINEERING
30 Cook Court
Laconia, New Hampshire 03246

AZIMUTH ELECTRONICS
2377 S. El Camino Real
San Clemente, CA 92672

Heat Sinks

Thermalloy 2266B (35°C/W)
IERC LAIC 3B4CB
IERC HP1-TO3-33CB (7°C/W)
AAVID 5791B

IERC
135 W. Magnolia Blvd.
Burbank, CA 91502

KEYSTONE ELECTRONICS CORP.
49 Bleecker St.
New York, N.Y. 10012

Mica Washers

Keystone 4658

ROBINSON NUGENT INC.
800 E. 8th St.
New Albany, IN 47150

THERMALLOY
P. O. Box 34829
Dallas, Texas 75234

MAGNETIC COMPONENTS MANUFACTURERS**Cores**

ARNOLD ENGINEERING CO.
300 West St.
Marengo, ILL. 60152

FERROXCUBE
5038 Kings Highway
Saugerties, N.Y. 12477

MAGNETICS
P. O. Box 391
Butler, PA 16001

FERRONICS, INC.
60 N. Lincoln Rd.
E. Rochester, N.Y. 14445

Pre-Wound Inductors

GFS MANUFACTURING CO., INC.
6 Progress Drive
Dover, N.H. 03820

RENCO ELECTRONICS
60 Jeffryn Boulevard
East Deer Park, N.Y. 11729

LOW ESR-TYPE CAPACITORS**SPRAGUE**

Type 672D Aluminum Electrolytics
Type 32DR Aluminum Electrolytics
Type 622D Aluminum Electrolytics

MEPCO/ELECTRA INC.

Series 3428 Aluminum Electrolytics
Series 3191 Aluminum Electrolytics
Series 3120 Aluminum Electrolytics

MALLORY

Type TT Aluminum Electrolytics
Types CG/CGS/TCG Aluminum Electrolytics

SANGAMO

Type 301 Aluminum Electrolytics

SPRAGUE

481 Marshall St.
North Adams, MA 01247

MEPCO/ELECTRA INC.
265 Industrial Dr.
Roxboro, NC 27573

SANGAMO

P. O. Box 128
Pickens, SC 29671

MALLORY

P. O. Box 1284
Indianapolis, IN 46206

LF13006/LF13007 Precision Digital Gain Set Applications

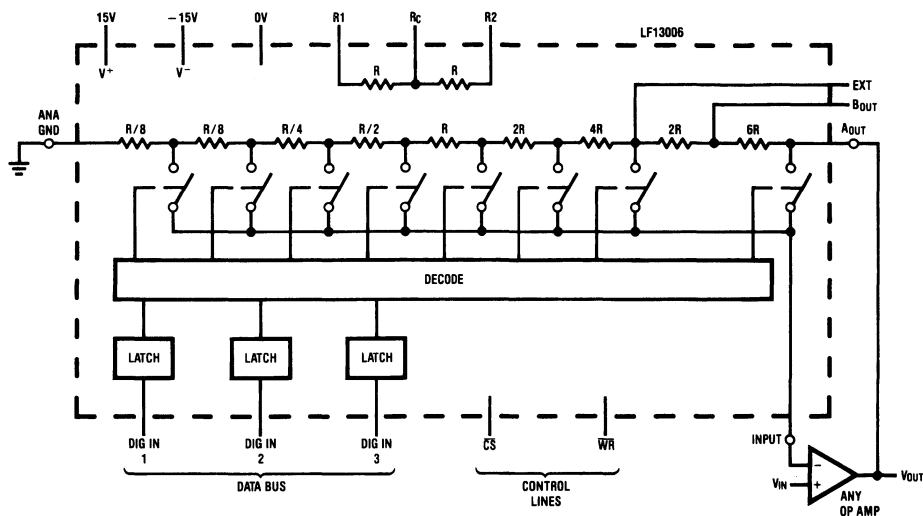
National Semiconductor
Application Note 344



AN-344

Some basic circuit configurations for using the LF13006 and LF13007 are shown in *Figures 1 through 4*. In each case only the Digital Gain Set and an op-amp are required, although in some instances the amplifier may need external compensation in order to maintain stability over wide ranges

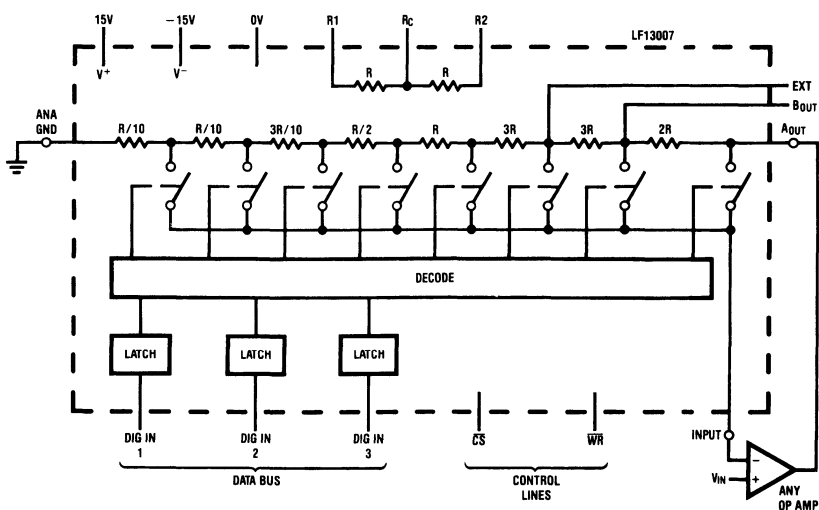
of closed loop gain. As shown, inverting and noninverting configurations are possible with several variations. Nearly unlimited values of gain can be realized using different combinations of outputs and/or the additional resistors at R1, Rc, and R2 to modify an amplifier's input or feedback.



Note: $1R = 15\text{ k}\Omega$

FIGURE 1A. LF13006, GAIN = 1 to 128 in Binary Sequence

TL/H/5513-1



Note: $1R = 15\text{ k}\Omega$

FIGURE 1B. LF13007, GAIN = 1 to 100 in "1, 2, 5" Sequence

TL/H/5513-2

Of significant interest are circuits such as in *Figure 3*, which allow gain switching at values near one. These configurations can be useful where in-circuit trimming may be needed for small, narrow range adjustments. Also, by cascading two circuits, high resolution as well as wide gain range can be realized. For example, by using *Figure 4* in conjunction with

1A, the programmed gains of 1.2 and 1.7 can be used to "fill in" between the binary steps supplied by *7A*. In audio applications, this particular arrangement would provide steps of 3 dB or less over a 46 dB range and slightly larger steps to 57 dB.

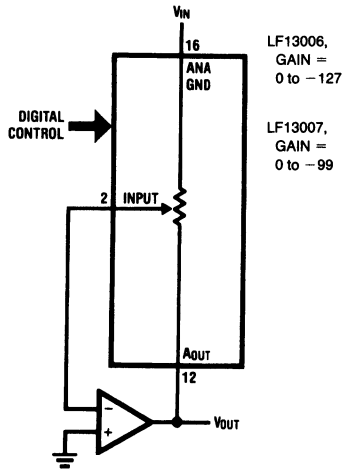


FIGURE 2. Inverting Mode

TL/H/5513-3

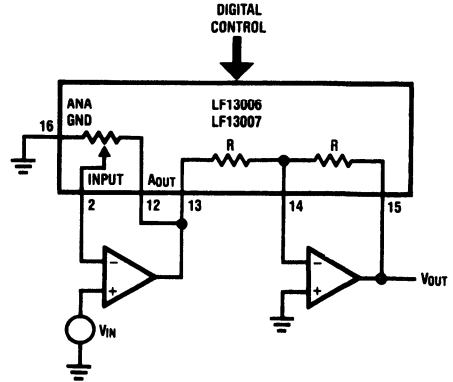


FIGURE 2A. High Input Impedance Inverting Mode

TL/H/5513-4

GAIN (LF13006)

- 9
- 1.8
- 1.29
- 1.125
- 1.059
- 1.029
- 1.014
- 1.007

GAIN (LF13007)

- 11
- 3.67
- 1.83
- 1.2
- 1.1
- 1.048
- 1.02
- 1.01

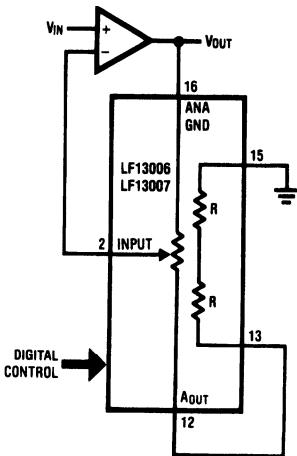


FIGURE 3. Variable Gains of Almost 1

TL/H/5513-5

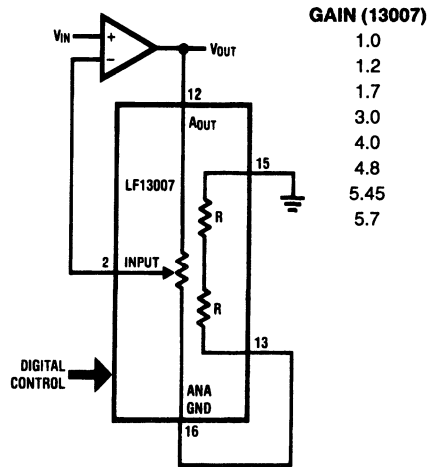


FIGURE 4. Altered Gain Range

TL/H/5513-6

GAIN (13007)

- 1.0
- 1.2
- 1.7
- 3.0
- 4.0
- 4.8
- 5.45
- 5.7

Applications for these devices also include a wide variety of circuits besides those which simply switch op-amp gain. A simple digital "handle" on one or more other circuit parameters can do a great deal to enhance the capabilities of many analog designs. In circuits such as filters, precision references, current sources, and countless others, the addition of programming capability can be invaluable.

One good example of such versatility is shown in a digitally adjustable low pass filter in *Figure 5*. Applications for this function include variable bandwidth front-ends for data acquisition and "smart" filters for DC signals which combine fast settling with high noise rejection. This can be done by increasing bandwidth in the presence of a large input-to-output differential at the filter, and then cutting back as the output gets close to its final level. The corner frequency is easily set via the 3-bit code input to an LF13006 or 7. When using the LF13006, time constants from $R \times C1$ to $128R \times C1$ can be programmed in binary weighted steps. The same function performed with a conventional CMOS DAC would need more bits to cover the same range and would still not be able to maintain the precision of setting at its limits of operation.

Time Constant $t = NRC_1$

$N =$ Set gain in basic configuration ($N =$ GAIN of Fig 1)

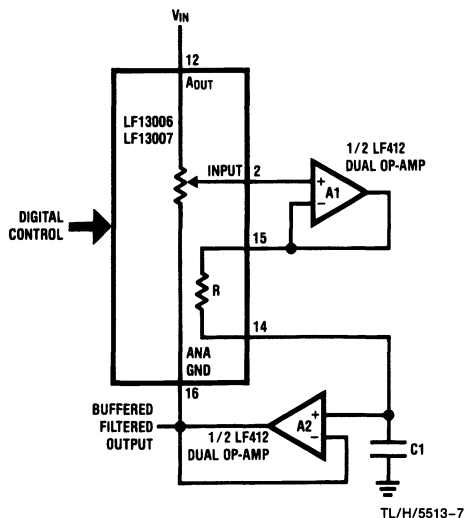


FIGURE 5. Variable Time Constant Filter

Circuit operation of the variable low pass is very straightforward. The LF13006 Network along with an LF412 dual op-amp form a resistance "multiplier" in which a settable fraction of the input voltage is used to determine the charge or discharge current through R into C1. One half of the dual amplifier (A1) is used to buffer the LF13006's "output" (Input, pin 2) and provide charging current for C1, while the second op-amp (A2) allows the resistor ladder to float on C1. In addition, the ratio of the selected time-constants will be very precise since these will be proportional to the LF13006's gain accuracy.

To a similar end, a classical capacitance multiplier can be made programmable with the circuit of *Figure 6*. The Digital Gain Set controls what is in effect a high input-impedance inverting amplifier which is used to drive the lower side of C1. The value of the "virtual" capacitor seen at the circuit's input will be C1 multiplied by the programmed gain. A drawback of this scheme is that the signal swing at A1's output can be large and may cause amplifier saturation. Thus for high capacitance multiplication factors, the input swing must be kept small in order to prevent clipping.

$C_{\text{effective}} = C_1 N$

$N =$ GAIN of Fig 1

Note: Output swing at input op amp is multiplied by set gain. Signal range may be limited.

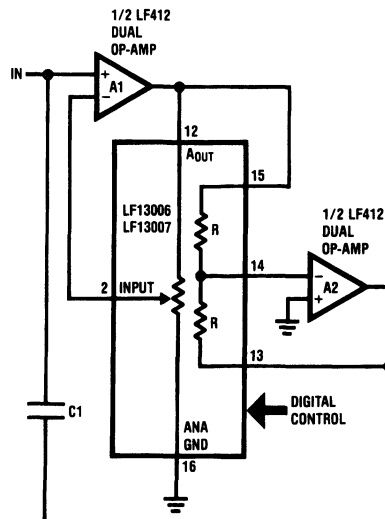


FIGURE 6. Variable Capacitance Multiplier

In *Figure 7*, an LF13006 is used to switch a single amplifier's gain but not quite in the conventional sense in this case. The LF411 op-amp can be flipped from a follower to an inverter using no additional parts and only the "Dig. In 1" input (pin 8) of the gain network. This "two part" approach can be used in precision rectifier and synchronous modulator/demodulator circuits as well as for polarity inverters in front of A to D converters.

The two extra matched resistors that are provided at R1, R2, and Rc (pins 13, 14, 15) are used to set the inverter gain while two of the internal switches are configured to switch the op-amp's noninverting input. The 8R resistor (approximately 120K) which exists from the circuit input to ground is not actually needed but is an unavoidable result of this particular switch connection.

In another example, a precision current source can be given direct digital control by using the simple scheme shown in *Figure 8*. Here, the current source's reference is "floated" on the load terminal (I_{OUT}) by using one half of a Bi-Fet dual op-amp (LF412, A1) as a buffer for the output. This provides a current return path for the gain set's resistor ladder and the circuit's reference (LM385-1.2) which doesn't interfere with the main output. The other half of the Bi-Fet dual (A2) is used to supply the output current via the sense resistor, R1. The current source's output is varied by changing the fraction of the reference voltage which will be forced to appear

across R1. With this scheme, the output current is governed by the equation; $I_{OUT} = V_{REF}/(R1 \times \text{Set Gain})$.

Applications for the above circuit include bias sources for programmable amplifiers, linear ramp generators, and variable current limiters. For greater output currents, R1 can be reduced and an external pass transistor can be added to A2's output.

A common need in data acquisition systems is for a differential input amplifier, or instrumentation amplifier, with easily adjustable precision gains. Normally this can't be done without using several precision resistors and switches or employing expensive modular products that have this capability already built in. In *Figure 9*, a differential gain can be varied by using one Digital Gain Set in one version of a three op-amp instrumentation amp circuit. The amplifier's front end uses an LF412A precision dual op-amp as a follower (A1) and also as a variable gain inverter (A2), both which drive the inputs of a fixed gain difference amp (LF411). The instrumentation amp's common-mode performance will directly depend on the four external resistors. For designs where common-mode rejection is critical, close matching of resistor pairs R1, R2 and R3, R4 are required, i.e. 60 dB DC CMRR requires 0.1% matching. However, reasonable rejection can still be achieved (54 dB typ) if only two external resistors are used and the gain set's uncommitted resistors serve as R1 and R2.

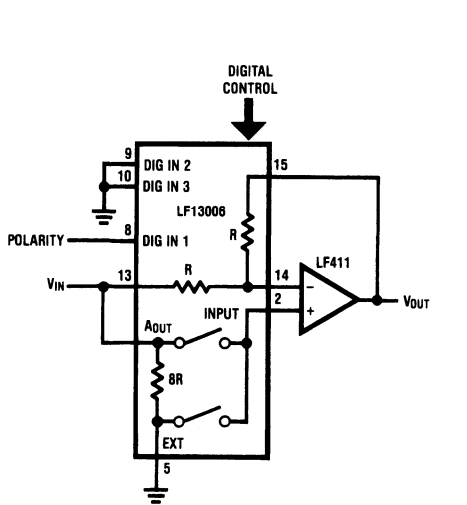


FIGURE 7. Switchable Gain of ± 1

TL/H/5513-9

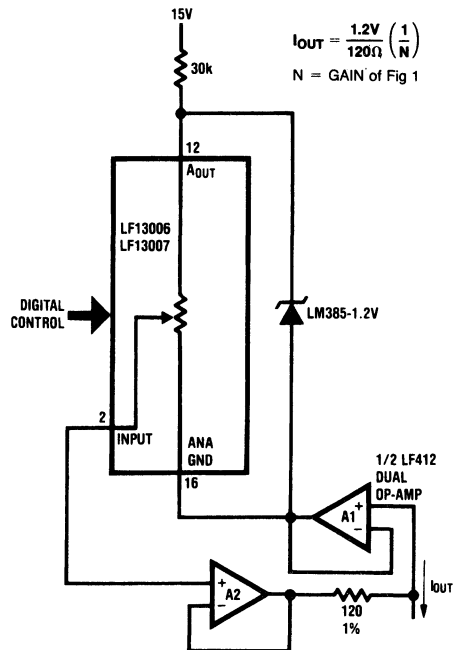


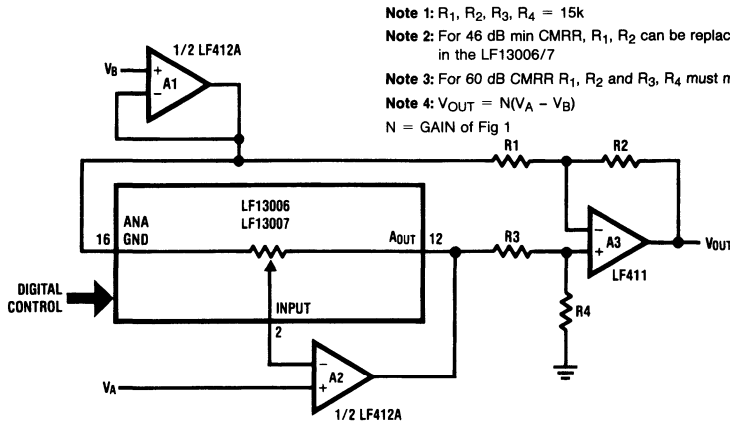
FIGURE 8. Programmable Current Source

TL/H/5513-10

In Figure 10, the programmable function generator shown will shift its operating frequency one octave for each LSB change in the program code. Triangle square-wave and sinewave outputs are available over an eight octave range. If an LF13007 were to be used rather than the 13006, the 1, 2, 5 sequence would provide ideal scaling for horizontal sweep or other scanning circuits.

This particular function generator employs 3/4 of a quad op-amp as an integrator, comparator, and buffer. The integrator

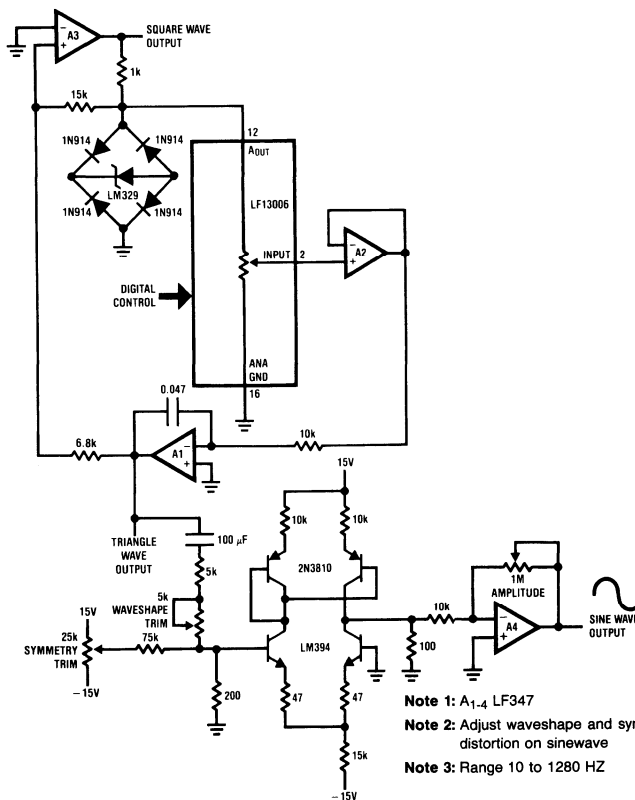
(A1) is driven from a controllable source which is simply the Digital Gain Set used as a passive voltage divider, and buffered by A2. The triangle output from A1 is used to drive a sine shaping circuit consisting of the last quarter of the LF347 (A4) and two dual transistors. Sine distortion can be reduced to 0.5% by trimming the symmetry and waveshape adjustments provided. The circuits' frequency range as shown is from 10 to 1280 Hz.



- Note 1: R₁, R₂, R₃, R₄ = 15k
- Note 2: For 46 dB min CMRR, R₁, R₂ can be replaced by internal resistors in the LF13006/7
- Note 3: For 60 dB CMRR R₁, R₂ and R₃, R₄ must match to 0.1%
- Note 4: V_{OUT} = N(V_A - V_B)
N = GAIN of Fig 1

FIGURE 9. Programmable Instrumentation Amp

TL/H/5513-11



- Note 1: A₁₋₄ LF347
- Note 2: Adjust waveshape and symmetry trims for lowest output distortion on sinewave
- Note 3: Range 10 to 1280 HZ

FIGURE 10. One Octave per Bit Function Generator

TL/H/5513-12

High-Performance Audio Applications of The LM833

National Semiconductor
Application Note 346
Kerry Lacanette

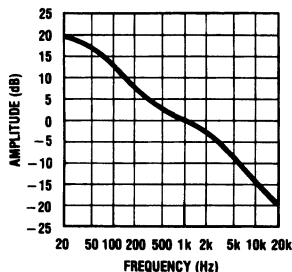


Designers of quality audio equipment have long recognized the value of a low noise gain block with "audiophile performance". The LM833 is such a device: a dual operational amplifier with excellent audio specifications. The LM833 features low input noise voltage (4.5 nV/ $\sqrt{\text{Hz}}$ typical), large gain-bandwidth product (15 MHz), high slew rate (7V/ μSec), low THD (0.002% 20 Hz-20 kHz), and unity gain stability. This Application Note describes some of the ways in which the LM833 can be used to deliver improved audio performance.

I. TWO STAGE RIAA PHONO PREAMPLIFIER

A phono preamplifier's primary task is to provide gain (usually 30 to 40 dB at 1 kHz) and accurate amplitude and phase equalization to the signal from a moving magnet or a moving coil cartridge. (A moving coil device's output voltage is typically around 20 dB lower than that of a moving magnet pickup, so this signal is usually amplified by a step-up device—either an active circuit or a transformer—before being applied to the input of the phono preamplifier). In addition to the amplification and equalization functions, the phono preamp must not add significant noise or distortion to the signal from the cartridge.

Figure 1 shows the standard RIAA phono preamplifier amplitude response. Numerical values relative to the 1 kHz gain are given in Table I. Note that the gain rolls off at a 6 dB/octave rate above 2122 Hz. Most phono preamplifier circuits in commercially available audio products, as well as most published circuits, are based on the topology shown in Figure 2(a). The network consisting of R_1 , R_2 , C_1 , and C_2 is not unique, and can be replaced by any of several other networks that give equivalent results. R_0 is generally well under 1k to keep its contribution to the input noise voltage below that of the cartridge itself. The 47k resistor shunting the input provides damping for moving-magnet phono cartridges. The input is also shunted by a capacitance equal to the sum of the input cable capacitance and C_p . This capacitance resonates with the inductance of the moving magnet cartridge around 15 kHz to 20 kHz to determine the frequency response of the transducer, so when a moving magnet pickup is used, C_p should be carefully chosen so that the total capacitance is equal to the recommended load capacitance for that particular cartridge.



TL/H/5520-1

FIGURE 1. Standard RIAA phonograph preamplifier frequency response curve. Gain continues to roll off at a 6 dB/octave rate above 20 kHz.

Table I. RIAA standard response referred to gain a 1 kHz.

FREQUENCY (Hz)	AMPLITUDE (dB)	FREQUENCY (Hz)	AMPLITUDE (dB)
20	+19.3	800	+0.7
30	+18.6	1000	0.0
40	+17.8	1500	-1.4
50	+17.0	2000	-2.6
60	+16.1	3000	-4.8
80	+14.5	4000	-6.6
100	+13.1	5000	-8.2
150	+10.3	6000	-9.6
200	+8.2	8000	-11.9
300	+5.5	10000	-13.7
400	+3.8	15000	-17.2
500	+2.6	20000	-19.6

The circuit of *Figure 2(a)* has a disadvantage: it cannot accurately follow the curve in *Figure 1*, no matter what values are chosen for the feedback resistors and capacitors. This is because the non-inverting amplifier cannot have a gain of less than unity, which means that the high frequency gain cannot roll off continuously above the 2122 Hz breakpoint as it is supposed to. Instead, a new breakpoint is introduced at the unity gain frequency.

In addition to the amplitude response errors (which can be made small through careful design), the lack of a continued rolloff can cause distortion in later stages of the audio system by allowing high frequency signals from the pickup cartridge to pass through the phono equalizer without sufficient attenuation. This is generally not a problem with moving magnet cartridges, since they are usually severely band-limited above 20 kHz due to the electrical resonance of cartridge inductance and preamp input capacitance. Moving coil cartridges, however, have very low inductance, and can produce significant output at frequencies as high as 150 kHz. If a subsequent preamplifier stage or power amplifier suffers from distortion caused by slew-rate limitations, these ultrasonic signals can cause distortion of the audio signal even though the signals actually causing the distortion are inaudible.

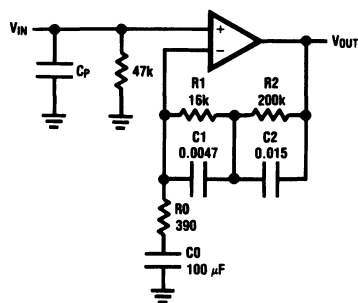
Preamplifiers using the topology of *Figure 2(a)* can suffer from distortion due to input stage nonlinearities that are not corrected by the feedback loop. The fact that practical amplifiers have non-infinite common mode rejection ratios means that the amplifier will have a term in its gain function that is dependent on the input voltage level. Since most good operational amplifiers have very high common mode rejection ratios, this form of distortion is usually quite difficult to find in opamp-based designs, but it is very common in discrete amplifiers using two or three transistors since these circuits generally have poor common mode performance. Another source of input stage distortion is input impedance nonlinearity. Since the input impedance of an amplifier can vary depending on the input voltage, and the signal at the amplifier input will be more strongly affected by input impedance if the source impedance is high, distortion will generally increase as the source impedance increases. Again, this problem will typically be significant only when the amplifier is a simple discrete design, and is not generally troublesome with good op amp designs.

The disadvantages of the circuit configuration of *Figure 2(a)* have led some designers to consider the use of RIAA preamplifiers based on the inverting topology shown in *Figure 2(b)*. This circuit can accurately follow the standard RIAA

response curve since the absolute value of its gain can be less than unity. The reduced level of ultrasonic information at its output will sometimes result in lower perceived distortion (depending on the design of the other components in the audio system). Since there is no voltage swing at the preamplifier input, distortion will be lower in cases where the gain block has poor common-mode performance. (The common-mode distortion of the LM833 is low enough that it exhibits essentially the same THD figures whether it is used in the inverting or the non-inverting mode.)

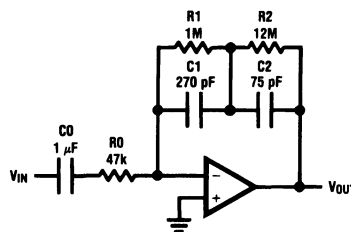
The primary handicap of the inverting configuration is its noise performance. The 47k resistor in series with the source adds at least $4 \mu\text{V}$ of noise (20 Hz to 20 kHz) to the preamplifier's input. In addition to $4 \mu\text{V}$ of thermal noise from the 47k resistor, the high impedance in series with the preamp input will generally result in a noise increase due to the preamplifier's input noise current, especially when the series impedance is made even larger by a moving magnet cartridge at resonance. In contrast, the 47k damping resistor in *Figure 2(a)* is in parallel with the source, and is a significant noise contributor only when the source impedance is high. This will occur near resonance, when the source is a moving magnet cartridge. Since the step-up devices used with moving coil cartridges present a low, primarily resistive source impedance to the preamplifier input, the effects of cartridge resonance and input noise current are virtually eliminated for moving coil sources. Therefore, the circuit of *Figure 2(a)* has a noise advantage of about 16 dB with a moving coil source, and from about 13 dB to about 18 dB (depending on the source impedance and on the input noise current of the amplifier) with a moving magnet source. Using the component values shown, the circuit in *Figure 2(a)* follows the RIAA characteristic with an accuracy of better than 0.5 dB (20–20 kHz) and has an input-referred noise voltage equal to $0.33 \mu\text{V}$ over the Audio frequency range.

Even better performance can be obtained by using the two-amplifier approach of *Figure 3*. The first operational amplifier takes care of the 50 Hz and 500 Hz breakpoints, while the 2122 Hz rolloff is accomplished by the passive network R_3 , R_6 , and C_3 . The second amplifier supplies additional gain—10 dB in this example. Using two amplifiers results in accurate conformance to the RIAA curve without reverting to the noisy inverting topology, as well as lower distortion due to the fact that each amplifier is operating at a lower gain than would be the case in a single-amplifier design. Also, the amplifiers are not required to drive capacitive feedback networks with the full preamplifier output voltages, fur-



(a)

TL/H/5520-2



(b)

TL/H/5520-16

FIGURE 2. Two typical operational amplifier-based phonograph preamplifier circuits. (a) Non-inverting. (b) Inverting.

ther reducing distortion compared to the single-amplifier designs.

The design equations for the preamplifier are:

1) $R_1 = 8.058 R_0 A_1$, where A_1 is the 1 kHz voltage gain of the first amplifier.

2) $C_1 = \frac{3.18 \times 10^{-3}}{R_1}$

3) $R_2 = \frac{R_1}{9} - R_0$

4) $C_3 = 7.5 \times 10^{-5} \frac{(R_3 + R_6)}{R_3 R_6} = \frac{7.5 \times 10^{-5}}{R_P}$

5) $C_4 = \frac{1}{2\pi f_L (R_3 + R_6)}$

where f_L is the low-frequency -3 dB corner of the second stage. For standard RIAA preamplifiers, f_L should be kept well below the audible frequency range. If the preamplifier is to follow the IEC recommendation (IEC Publication 98, Amendment #4), f_L should equal 20.2 Hz.

6) $A_{V2} = 1 + \frac{R_5}{R_4}$

where A_{V2} is the voltage gain of the second amplifier.

7) $C_0 \approx \frac{1}{2\pi f_0 R_0}$

where f_0 is the low-frequency -3 dB corner of the first amplifier. This should be kept well below the audible frequency range.

A design procedure is shown below with an illustrative example using 1% tolerance E96 components for close conformance to the ideal RIAA curve. Since 1% tolerance capacitors are often difficult to find except in 5% or 10% standard values, the design procedure calls for re-calculation of a few component values so that standard capacitor values can be used.

RIAA PHONO PREAMPLIFIER DESIGN PROCEDURE

- 1) Choose R_0 . R_0 should be small for minimum noise contribution, but not so small that the feedback network excessively loads the amplifier.

Example: Choose $R_0 = 500$.

- 2) Choose 1 kHz gain, A_{V1} of first amplifier. This will typically be around 20 dB to 30 dB.

Example: Choose $A_{V1} = 26$ dB = 20.

- 3) Calculate $R_1 = 8.058 R_0 A_{V1}$

Example: $R_1 = 8.058 \times 500 \times 20 = 80.58k$.

4) Calculate $C_1 = \frac{3.18 \times 10^{-3}}{R_1}$

Example: $C_1 = \frac{3.18 \times 10^{-3}}{8.058 \times 10^4} = 0.03946 \mu\text{F}$

- 5) If C_1 is not a convenient value, choose the nearest convenient value and calculate a new R_1 from

$$R_1 = \frac{3.18 \times 10^{-3}}{C_1}$$

Example: New $C_1 = 0.039 \mu\text{F}$.

$$\text{New } R_1 = \frac{3.18 \times 10^{-3}}{3.9 \times 10^{-8}} = 81.54k$$

Use $R_1 = 80.6k$.

6) Calculate a new value for R_0 from $R_0 = \frac{R_1}{8.058 A_{V1}}$

Example: New $R_0 = \frac{80.6 \times 10^4}{8.058 \times 20} = 498.8$.

Use $R_0 = 499$.

7) Calculate $R_2 = \frac{R_1}{9} - R_0$

Example: $R_2 = \frac{80.6 \times 10^4}{9} - 499 = 8456.56$

Use 8.45k.

- 8) Choose a convenient value for C_3 in the range from 0.01 μF to 0.05 μF .

Example: $C_3 = 0.033 \mu\text{F}$.

9) Calculate $R_P = \frac{7.5 \times 10^{-5}}{C_3}$

Example: $R_P = \frac{7.5 \times 10^{-5}}{3.3 \times 10^{-8}} = 2.273k$.

- 10) Choose a standard value for R_3 that is slightly larger than R_P .

Example: $R_3 = 2.37k$.

- 11) Calculate R_6 from $1/R_6 = 1/R_P - 1/R_3$

Example: $R_6 = 55.36k$

Use 54.9k.

- 12) Calculate C_4 for low-frequency rolloff below 1 Hz from design equation (5).

Example: $C_4 = 2 \mu\text{F}$. Use a good quality mylar, polystyrene, or polypropylene.

- 13) Choose gain of second amplifier.

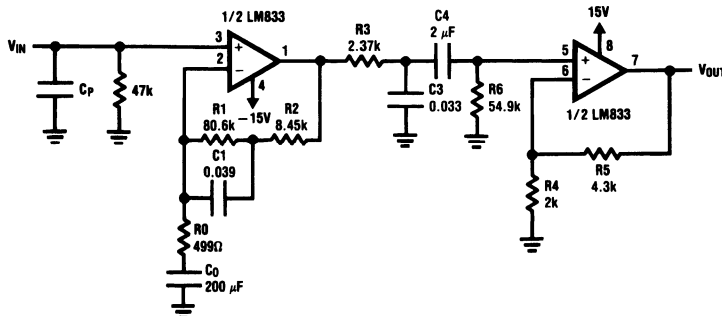


FIGURE 3. Two-amplifier RIAA phono preamplifier with very accurate RIAA response.

Example: The 1 kHz gain up to the input of the second amplifier is about 26 dB for this example. For an overall 1 kHz gain equal to about 36 dB we choose:

$$A_{V2} = 10 \text{ dB} = 3.16.$$

14) Choose value for R_4 .

Example: $R_4 = 2k$.

15) Calculate $R_5 = (A_{V2} - 1) R_4$

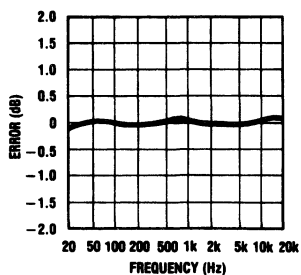
Example: $R_5 = 4.32k$.

Use $R_5 = 4.3k$

16) Calculate C_0 for low-frequency rolloff below 1 Hz from design equation (7).

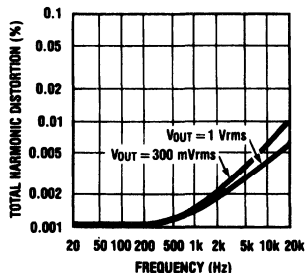
Example: $C_0 = 200 \mu\text{F}$.

The circuit of *Figure 3* has excellent performance: Conformance to the RIAA curve is within 0.1 dB from 20 Hz to 20 kHz, as illustrated in *Figure 4* below for a prototype version of the circuit. THD and noise data are reproduced in *Figure 5* and *Table II*, respectively. If a "perfect" cartridge with 1mV/cm/s sensitivity (higher than average) is used as the input to this preamplifier, the highest recorded groove velocities available on discs (limited by the cutting equipment) will fall below the 1V curve except in the 1 kHz to 10 kHz region, where isolated occurrences of 2V to 3V levels can be generated by one or two of the "superdiscs". (See reference 4). The distortion levels at those frequencies and signal levels are essentially the same as those shown on the 1V curve, so they are not reproduced separately here. It should be noted that most real cartridges are very limited in their ability to track such large velocities, and will not generate preamplifier output levels above 1Vrms even under high groove velocity conditions.



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FIGURE 4. Deviation from Ideal RIAA response for circuit of *Figure 3* using 1% resistors. The maximum observed error for the prototype was 0.1 dB.



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FIGURE 5. THD of circuit in *Figure 3* as a function of frequency. The lower curve is for an output level of 300mVrms and the upper curve is for an output level of 1Vrms.

Table II. Equivalent input noise and signal-to-noise ratio for RIAA preamplifier circuit of *Figure 3*. Noise levels are referred to gain at 1 kHz.

NOISE WEIGHTING	CCIR/ARM	"A"	FLAT
Noise voltage	0.26 μV	0.23 μV	0.37 μV
S/N referred to 5 mV input at 1 kHz	86 dB	87 dB	82 dB

II. ACTIVE CROSSOVER NETWORK FOR LOUSPEAKERS

A typical multi-driver loudspeaker system will contain two or more transducers that are intended to handle different parts of the audio frequency spectrum. Passive filters are usually used to split the output of a power amplifier into signals that are within the usable frequency range of the individual drivers. Since passive crossover networks must drive loudspeaker elements whose impedances are quite low, the capacitors and inductors in the crossovers must be large in value, meaning that they will very likely be expensive and physically large. If the capacitors are electrolytic types or if the inductors do not have air cores, they can also be significant sources of distortion. Furthermore, many desirable filter characteristics are either impossible to realize with passive circuitry, or require so much attenuation to achieve passively that system efficiency is severely reduced.

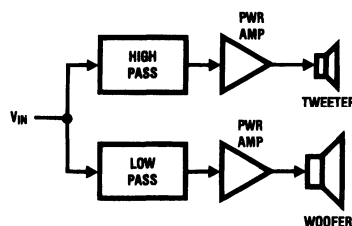
An alternative approach is to use low-level filters to divide the frequency spectrum, and to follow each of these with a separate power amplifier for each driver or group of drivers. A two-way (or "bi-amped") system of this type is shown in *Figure 6*. This basic concept can be expanded to any number of frequency bands. For accurate sound reproduction, the sum of the filter outputs should be equal to the crossover input (if the transducers are "ideal"). While this seems to be an obvious requirement, it is very difficult to find a commercial active dividing network that meets it. Consider an active crossover consisting of a pair of 2nd-order Butterworth filters, (one is a low-pass; the other is a high-pass). The transfer functions of the filters are of the form:

$$\frac{V_L(s)}{V_{in}(s)} = \frac{1}{s^2 + \sqrt{2}s + 1}$$

$$\frac{V_H(s)}{V_{in}(s)} = \frac{s^2}{s^2 + \sqrt{2}s + 1}$$

and their sum is:

$$\frac{V_L(s)}{V_{in}(s)} + \frac{V_H(s)}{V_{in}(s)} = \frac{1 + s^2}{s^2 + \sqrt{2}s + 1}$$



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FIGURE 6. Block diagram of a two-way loudspeaker system using a low level crossover network ahead of the power amplifiers.

The output will therefore never exactly equal the input signal (except in the trivial case of a DC input). *Figure 7* shows the response of this crossover to a square wave input, and the amplitude and phase response of the crossover to sinusoidal steady state inputs can be seen in *Figure 8*. Higher-order filters will yield similarly dissatisfying results when this approach is used.

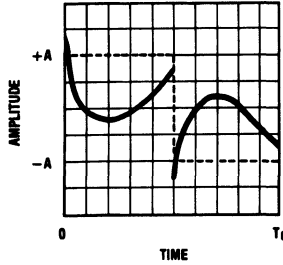
A significant improvement can be made by the use of a constant voltage crossover like the one shown in *Figure 9*. The term "constant voltage" means that the outputs of the high-pass and low-pass sections add up to produce an exact replica of the input signal. The rolloff rate is 12 dB/oct-

tave. The input impedance is equal to $R/2$, or 12 kΩ in the circuit of *Figure 9*. The LM833 is especially well-suited for active filter applications because of its high gain-bandwidth product. The transfer functions of this crossover network are of the form

$$\frac{V_L(s)}{V_{in}(s)} = \frac{a_1s + 1}{a_3s^3 + a_2s^2 + a_1s + 1}$$

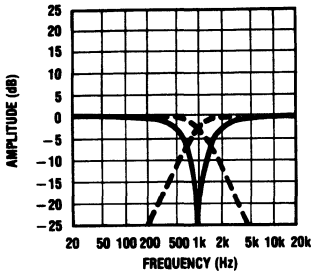
and

$$\frac{V_H(s)}{V_{in}(s)} = \frac{a_3s^3 + a_2s^2}{a_3s^3 + a_2s^2 + a_1s + 1}$$

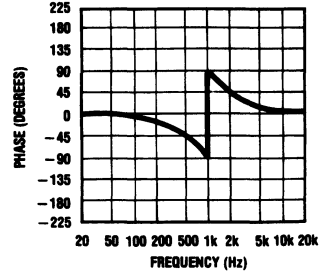


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FIGURE 7. Response of second-order Butterworth crossover network (high-pass and low-pass outputs summed) to a square wave input (dashed line) at the crossover frequency. Period is $T_C = 1/f_C$.

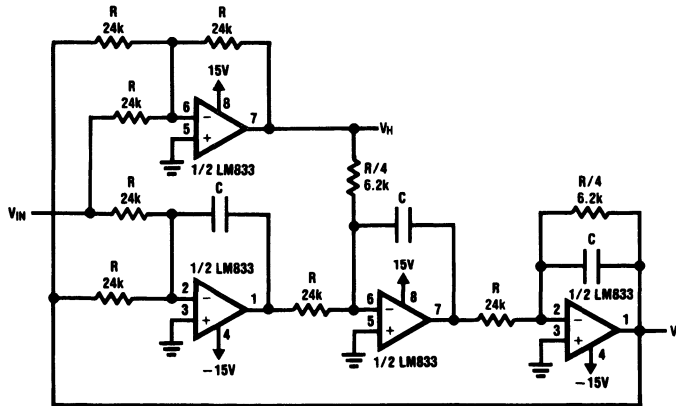


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FIGURE 8. Magnitude (a) and phase (b) response of a second-order, 1 kHz Butterworth crossover network with the high-pass and low-pass outputs summed. The individual high-pass and low-pass outputs are superimposed (dashed lines).

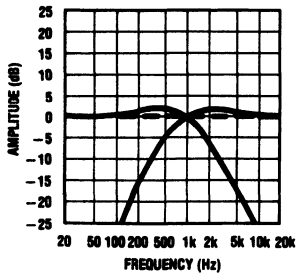


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FIGURE 9. Constant-voltage crossover network with 12 dB/octave slopes.

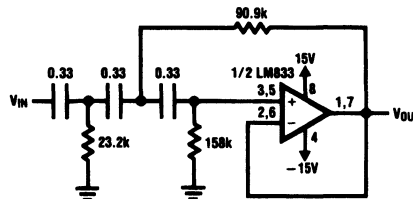
The crossover frequency is equal to $\frac{1}{2\pi RC}$.

The low-pass and high-pass constant voltage crossover outputs are plotted in Figure 10. The square-wave response (not shown) of the summed outputs is simply an inverted square-wave, and the phase shift (also not shown) is essentially 0° to beyond 20 kHz.



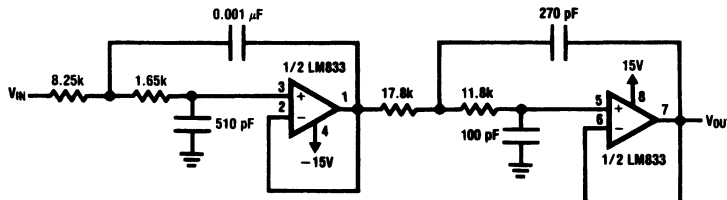
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FIGURE 10. Low-pass and high-pass responses of constant-voltage crossover network in Figure 9 with crossover frequency of 1 kHz. For the circuit of Figure 9, $a_1 = 4$, $a_2 = 4$, and $a_3 = 1$. Note that the summed response (dashed lines) is perfectly flat.



TL/H/5520-11

FIGURE 11. Filter for rejection of undesirable infrasonic signals. Filter characteristic is third-order Butterworth with -3 dB frequency at 15 Hz. Resistor and capacitor values shown are for 1% tolerance components. 5% tolerance units can be substituted in less critical applications.



TL/H/5520-12

FIGURE 12. Ultrasonic rejection filter with fourth-order Bessel low-pass characteristic. The filter gain is down 3 dB at about 40 kHz. As with the infrasonic filter, 1% tolerance components should be used for accurate response.

It is important to remember that even a constant voltage crossover transfer function does not guarantee an ideal overall system response, because the transfer functions of the transducers will also affect the overall response. This can be minimized to some extent by using drivers that are "flat" at least two octaves beyond the crossover frequency.

III. INFRASONIC AND ULTRASONIC FILTERS

In order to ensure "perfectly flat" amplitude response from 20 Hz to 20 kHz, many audio circuits are designed to have bandwidths extending far beyond the audio frequency range. There are many high-fidelity systems, however, that can be audibly improved by reducing the gain at frequencies above and below the limits of audibility.

The phonograph arm/cartridge/disc combination is the most significant source of unwanted low-frequency information. Disc warps on $33\frac{1}{3}$ rpm records can cause large-amplitude signals at harmonics of 0.556 Hz. Other large low-frequency signals can be created at the resonance frequency determined by the compliance of the pickup cartridge and the effective mass of the cartridge/arm combination. The magnitude of undesirable low-frequency signals can be especially large if the cartridge/arm resonance occurs

at a warp frequency. Infrasonic signals can sometimes overload amplifiers, and even in the absence of amplifier overload can cause large woofer excursions, resulting in audible distortion and even woofer damage.

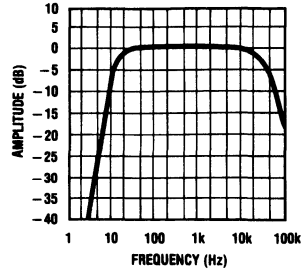
Ultrasonic signals tend to cause problems in power amplifiers when the amplifiers exhibit distortion mechanisms due to slow rate limitations and other high frequency nonlinearities. The most troublesome high-frequency signals come principally from moving-coil cartridges and sometimes from tape recorders if their bias oscillator outputs manage to get into the audio signal path. Like the infrasonic signals, ultrasonic signals can place distortion products in the audio band even though the offending signals themselves are not audible.

The circuits in *Figures 11 and 12* attenuate out-of-band signals while having minimal effect on the audio program. The infrasonic filter in *Figure 11* is a third-order Butterworth high-pass with its -3 dB frequency at 15 Hz. The attenuation at 5 Hz is over 28 dB, while 20 Hz information is reduced by only 0.7 dB and 30 Hz information by under 0.1 dB.

The ultrasonic filter in *Figure 12* is a fourth-order Bessel alignment, giving excellent phase characteristics. A Bessel filter approximates a delay line within its passband, so complex in-band signals are passed through the filter with negligible alteration of the phase relationships among the various in-band signal frequencies. The circuit shown is down 0.65 dB at 20 kHz and -3 dB at about 40 kHz. Rise time is limited to about 8.5 μ Sec.

The high-pass and low-pass filters exhibit extremely low THD, typically under 0.002%. Both circuits must be driven from low impedance sources (preferably under 100 ohms). 5% components will often yield satisfactory results, but 1% values will keep the filter responses accurate and minimize mismatching between the two channels. The amplitude response of the two filters in cascade is shown in *Figure 13*.

When the two filters are cascaded, the low-pass should precede the high-pass.

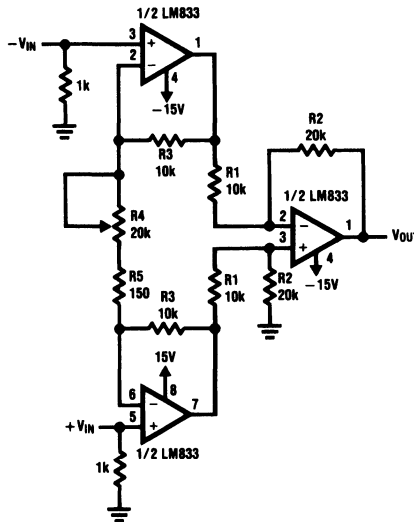


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FIGURE 13. Amplitude response of infrasonic and ultrasonic filters connected in series.

IV. TRANSFORMERLESS MICROPHONE PREAMPLIFIERS

Microphones used in professional applications encounter an extremely wide dynamic range of input sound pressure levels, ranging from about 30 dB SPL (ambient noise in a quiet room) to over 130 dB SPL. The output voltage of a low impedance (200 ohm) microphone over this range of SPLs might typically vary from 20 μ V to 2V rms, while its self-generated output noise would be on the order of 0.25 μ V over a 20 kHz bandwidth. Since the microphone's output dynamic range is so large, a preamplifier for microphone signals should have an adjustable gain so that it can be optimized for the signal levels that will be present in a given situation. Large signals should be handled without clipping or excessive distortion, and small signals should not be degraded by preamplifier noise.



TL/H/5520-14

FIGURE 14. Simple transformerless microphone preamplifier using LM833. R_1 , R_2 , and R_3 are 0.1% tolerance units (or R_2 can be trimmed).

For a conservative low noise design, the preamplifier should contribute no more noise to the output signal than does the resistive portion of the source impedance. In practical applications, it is often reasonable to allow a higher level of input noise in the preamplifier since ambient room noise will usually cause a noise voltage at the microphone output terminals that is on the order of 30 dB greater than the microphone's intrinsic (due to source resistance) noise floor.

When long cables are used with a microphone, its output signal is susceptible to contamination by external magnetic fields—especially power line hum. To minimize this problem, the outputs of most professional microphones are balanced, driving a pair of twisted wires with signals of opposite polarity. Ideally, magnetic fields will induce equal voltages on each of the two wires, which can then be cancelled if the signals are applied to a transformer or differential amplifier at the preamplifier input.

The circuits in Figures 14 and 15 are transformerless differential input microphone preamplifiers. Avoiding transformers has several advantages, including lower cost, smaller physical size, and reduced distortion. The circuit of Figure 14 is the simpler of the two, with two LM833s amplifying the input signal before the common-mode noise is cancelled in the differential amplifier. The equivalent input noise is about 760 nV over a 20 Hz to 20 kHz frequency band (-122 dB referred to 1V), which is over 26 dB lower than a typical microphone's output from the 30 dB SPL ambient noise level in a quiet room. THD is under .01% at maximum gain,

and .002% at minimum gain. For more critical applications with lower sensitivity microphones, the circuit of Figure 15 uses LM394s as input devices for the LM833 gain stages. The equivalent input noise of this circuit is about 2.4 nV/ $\sqrt{\text{Hz}}$, at maximum gain, resulting in a 20 Hz to 20 kHz input noise level of 340 nV, or -129 dB referred to 1V.

In both circuits, potentiometer R_4 is used to adjust the circuit gain from about 4 to 270. The maximum gain will be limited by the minimum resistance of the potentiometer. If R_1 , R_2 , and R_3 are all 0.1% tolerance units, the rejection of hum and other common-mode noise will typically be about 60 dB, and about 44 dB worst case. If better common-mode rejection is needed, one of the R_2 s can be replaced by an 18k resistor and a 5k potentiometer to allow trimming of CMRR. To prevent radio-frequency interference from getting into the preamplifier inputs, it may be helpful to place 470 pF capacitors between the inputs and ground.

References:

- 1) S. P. Lipshitz, J. Audio Eng. Soc., "On RIAA Equalization Networks", June 1979.
- 2) P. J. Baxandall, J. Audio Eng. Soc., Letter, pp47-52, Jan 1981.
- 3) Ashley and Kaminsky, J. Audio Eng. Soc., "Active and Passive Filters as Loudspeaker Crossover Networks", June 1971.
- 4) T. Holman, Audio, "Dynamic Range Requirements of Phonographic Preamplifiers", July 1977.

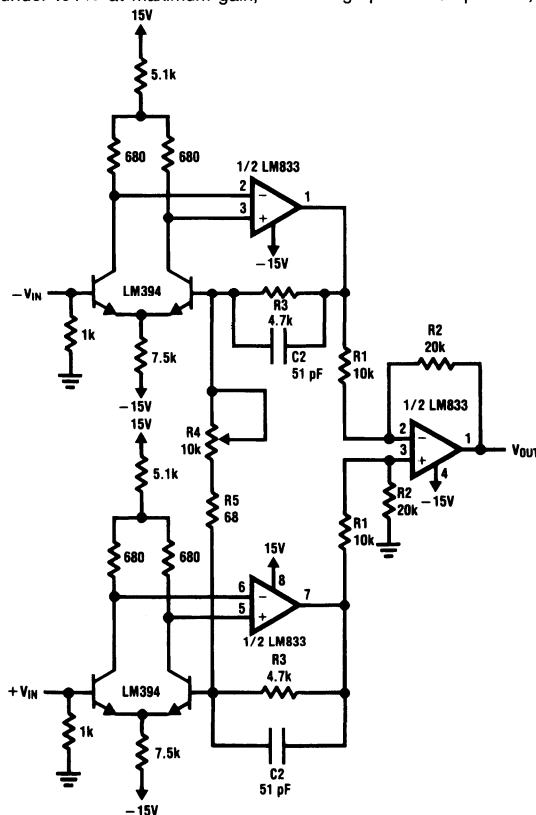


FIGURE 15. Transformerless microphone preamplifier similar to that of Figure 14, but using LM394s as low-noise input stages.

TL/H/5520-15

APPENDIX I: DERIVATION OF RIAA PHONO PREAMPLIFIER DESIGN EQUATIONS (1), (2), AND (3).

The first three design equations on the third page are derived here. The derivations of the others should be apparent by observation. The purpose of the preamplifier's first stage is to produce the transfer function:

$$A_V(s) = A_V(dc) \frac{(3.18 \times 10^{-4} + 1)}{(3.18 \times 10^{-3} + 1)} \quad (i)$$

where $A_V(dc)$ is the dc gain of the first stage.

The actual first stage transfer function is (ignoring C_0):

$$A_V(s) = \frac{sC_1(R_0R_1 + R_1R_2) + R_0 + R_1 + R_2}{sC_1R_0R_1 + R_0} \\ = \left[\frac{R_0 + R_1 + R_2}{R_0} \right] \left[\frac{sC_1 \frac{(R_0R_1 + R_1R_2)}{R_0 + R_1 + R_2} + 1}{sC_1R_1 + 1} \right] \quad (ii)$$

Equating terms, we have:

$$\frac{C_1(R_0R_1 + R_1R_2)}{R_0 + R_1 + R_2} = 3.18 \times 10^{-4} \quad (iii)$$

$$C_1R_1 = 3.18 \times 10^{-3} \quad (iv)$$

$$A_V(dc) = \frac{R_0 + R_1 + R_2}{R_0} \quad (v)$$

Note that (iv) is equivalent to (2) on page three.

From (iii) and (iv) we have:

$$\frac{C_1R_1(R_0 + R_2)}{R_0 + R_1 + R_2} = \frac{C_1R_1}{10} \quad (vi)$$

Therefore:

$$\frac{R_0 + R_1 + R_2}{R_0 + R_2} = 10 \quad (vii)$$

$$\frac{R_1}{R_0 + R_2} = 9 \quad (viii)$$

$$\text{and } R_2 = \frac{R_1}{9} - R_0 \quad (ix)$$

(ix) is equivalent to design equation (3) on page three.

Combining (v) and (ix),

$$A_V(dc) = \frac{R_0 + R_1 + R_2}{R_0} = \frac{R_1(1 + 1/9)}{R_0} \quad (x)$$

Finally, solving for R_1 and using $A_V(dc) = 8.9535A_V(1 \text{ kHz})$ yields:

$$R_1 = \frac{R_0A_V(dc)}{10/9} = 0.9R_0A_V(dc) = 8.058A_V(1 \text{ kHz})R_0, \quad (xi)$$

which is equivalent to (1) on page three.

APPENDIX II: STANDARD E96 (1%) RESISTOR VALUES

Standard Resistor Values (E-96 Series)							
10.0	13.3	17.8	23.7	31.6	42.2	56.2	75.0
10.2	13.7	18.2	24.3	32.4	43.2	57.6	76.8
10.5	14.0	18.7	24.9	33.2	44.2	59.0	78.7
10.7	14.3	19.1	25.5	34.0	45.3	60.4	80.6
11.0	14.7	19.6	26.1	34.8	46.4	61.9	82.5
11.3	15.0	20.0	26.7	35.7	47.5	63.4	84.5
11.5	15.4	20.5	27.4	36.5	48.7	64.9	86.6
11.8	15.8	21.0	28.0	37.4	49.9	66.5	88.7
12.1	16.2	21.5	28.7	38.3	51.1	68.1	90.9
12.4	16.5	22.1	29.4	39.2	52.3	69.8	93.1
12.7	16.9	22.6	30.1	40.2	53.6	71.5	95.3
13.0	17.4	23.2	30.9	41.2	54.9	73.2	97.6

An Auto-Error Correction, Auto-Gain Ranging Analog Data Acquisition System

National Semiconductor
Application Note 360



AN-360

INTRODUCTION

The range and accuracy of analog data acquisition systems can be greatly improved by the implementation of software error correction and gain ranging techniques. By utilizing software to correct system offset and gain errors, costly and repeated system calibration can be performed automatically.

The design of an automatic calibrating and ranging data acquisition system requires only the addition of a suitable reference and a microprocessor to an otherwise standard system. The result is a simple and accurate system capable of handling a wide range of analog signals.

Such a system is extremely useful in industrial control, instrumentation, or data-logging applications.

A system is described which employs a 12-bit A/D converter to maintain absolute accuracies of $\pm 0.02\%$ to $\pm 0.08\%$ over a gain range of 1 to 200, respectively, at 25°C ; and $\pm 0.035\%$ to $\pm 0.1\%$ over a -25°C to $+100^\circ\text{C}$ temperature range.

When a 12-bit A/D converter is preceded by a programmable-gain amplifier (gain range = 1 to 200), the system dynamic range can be increased to over 110 dB. Because such a system can handle a wide range of inputs, from 50 mV to 10V full-scale, low level signals from thermocouples, strain gauges, load cells and pressure transducers can be digitized with nearly the same accuracy as high level signals.

SYSTEM DESCRIPTION

In normal operation, the appropriate input scale is determined either automatically or from a stored table containing

gain settings for each channel. The ADC then digitizes the channel data. Zero-error data already stored in RAM for the present gain range is subtracted, giving data corrected for zero-error. This zero corrected binary data is converted to a floating-point decimal value, which is then multiplied by the previously stored decimal value of the least significant bit of the analog-to-digital converter, LSB, to find the true value of the input signal.

The auto-calibration portion of the operating program requires it to periodically calibrate both zero and gain factors for each gain range and save the results in RAM. The gain factor is represented by the decimal value of one LSB, which is used as the multiplicand to determine the system's true input value.

Automatic gain ranging is provided to scale the input for highest resolution.

Before using the system, a calibration of the reference and reference divider must be performed in the lab or field. The calibration values are stored in UVPRAM for use in system auto-calibration and auto-gain operations. The UVPRAM can then be revised as necessary to permit a periodic update of calibration data.

Hardware Implementation

Hardware implementation of the system includes a normal data acquisition configuration, i.e., a 12-bit ADC, sample-and-hold, programmable-gain amplifier, and input multiplexers. *Figure 1* is a block diagram of the circuit used, while *Figure 2* shows a detailed schematic.

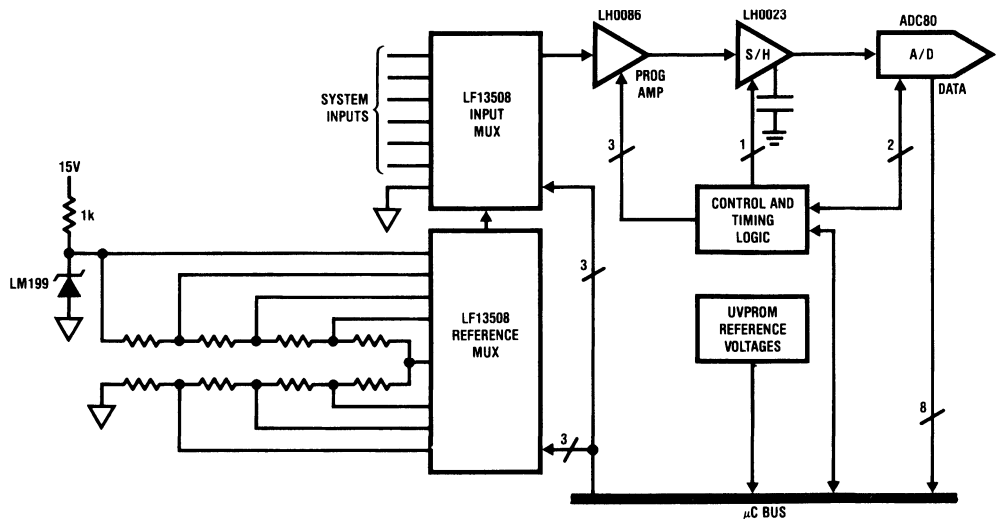
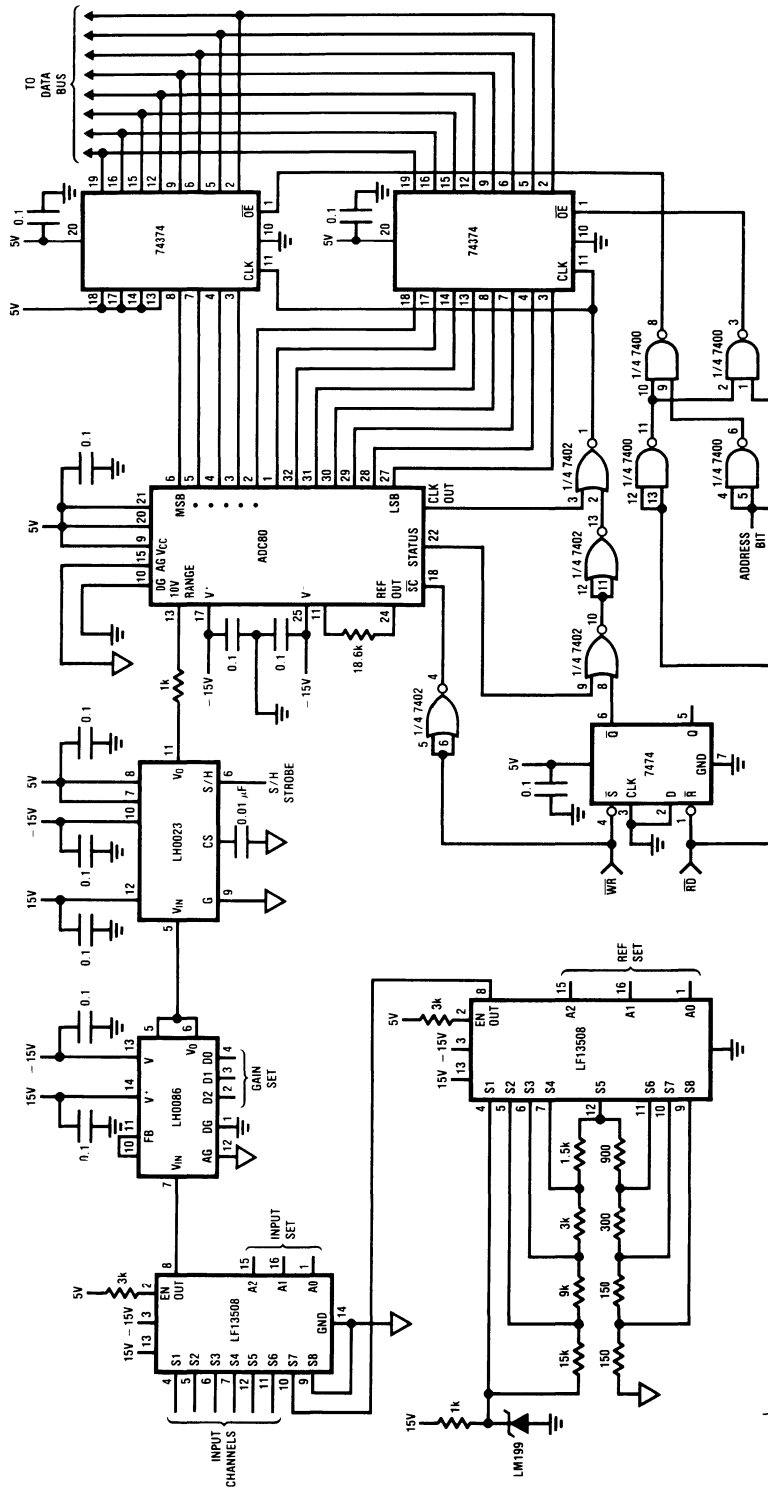


FIGURE 1. Block Diagram of Data Acquisition System

TL/K/6157-1



TL/K/6157-2

FIGURE 2. Schematic of Data Acquisition System

The system employs an industry standard 12-bit analog-to-digital converter, ADC80, featuring an internal clock and a conversion time of 22 μ s. The LH0023 sample-and-hold amplifier was selected because of its low drift rate of 500 μ V/sec and 0.01% accuracy. Faster S/H devices, such as the LF398, could be used at a slight sacrifice in accuracy or drift with time. The system has 8 gain ranges, with the ranging done in an LH0086 programmable-gain amplifier. The gain ranges of 1, 2, 5, 10, 20, 50, 100 and 200 are digitally controlled.

Two analog multiplexers are utilized; one for system inputs and the other for the reference that is necessary for gain error correction.

Calibrated Reference

The reference multiplexer samples the divided output from an LM199 ultrastable reference. A precision resistor ladder divides the reference by the same biquinary ratios as the gain ranges on the programmable amp; namely 1, 2, 5, 10, 20, 50, 100 and 200. The voltages of the divider network are measured with a 6½-digit DVM and stored in memory. This can be done once, or periodically, in the laboratory; and the calibration data placed in a UVPR0M until the next calibration.

By selecting the appropriate multiplexer address, either the system input, system ground, or the reference input can be chosen for processing.

Software control is provided through interface with an 8080-based microcomputer, although the operation could be speeded with other microprocessors.

SYSTEM OPERATION

System operation is outlined in the flowchart of *Figure 3*.

The input multiplexer is addressed to read both system ground and the reference divider for each gain range, with the digital representations obtained from the ADC stored in RAM for subsequent use in auto-zero and auto gain scale calibration.

Since an ADC's output is in binary form, it must be converted to decimal, then multiplied by the system LSB value to obtain the corrected analog input value. This LSB value also allows gain scale error correction.

The LSB in each range is computed by dividing the reference voltage (previously measured for each gain range and stored in UVPR0M) by the difference of the binary codes representing the reference and analog ground. Since any errors appear in both reference and zero scale readings, they cancel out when subtracted and have no affect on the calculation. These LSB values are stored in RAM for later calibration use.

Determining Amplifier Gain

The proper amplifier gain may be found either automatically or from a stored table containing gain settlings for each channel. One way to accomplish this automatically is to obtain a digital representation of the input channel from the ADC, subtract the zero-error data already stored in RAM (for unity-gain), and use the result to control the gain. A stored look-up table permits faster operation while the automatic procedure offers greater flexibility.

Auto-Zero and Auto-Gain Scale Correction

With the amplifier set for the appropriate gain, a digital representation of the input channel data is obtained from the ADC and stored in memory. The zero-error data for that gain is subtracted to correct for all system offset errors. This result is multiplied by the LSB value for that gain to obtain the true input reading.

Not only does the LSB value correct for full-scale error in the ADC and gain errors in the amplifier and S/H, it also rescales the answer to its original level.

Auto-Ranging

Some means must be provided to allow for automatic gain ranging in case the input voltage has changed since the last conversion loop, or if different input channels have different signal ranges. This is accomplished by testing the corrected result to ascertain if up or down gain ranging is required. If ranging is required, the program increments or decrements the previous amplifier gain setting and repeats the conversion. If the result lies within the proper window, i.e., between approximately half and full-scale (large enough so that increasing gain would result in an overrange condition), it can then be stored in memory, displayed on a CRT, or used to control some other process.

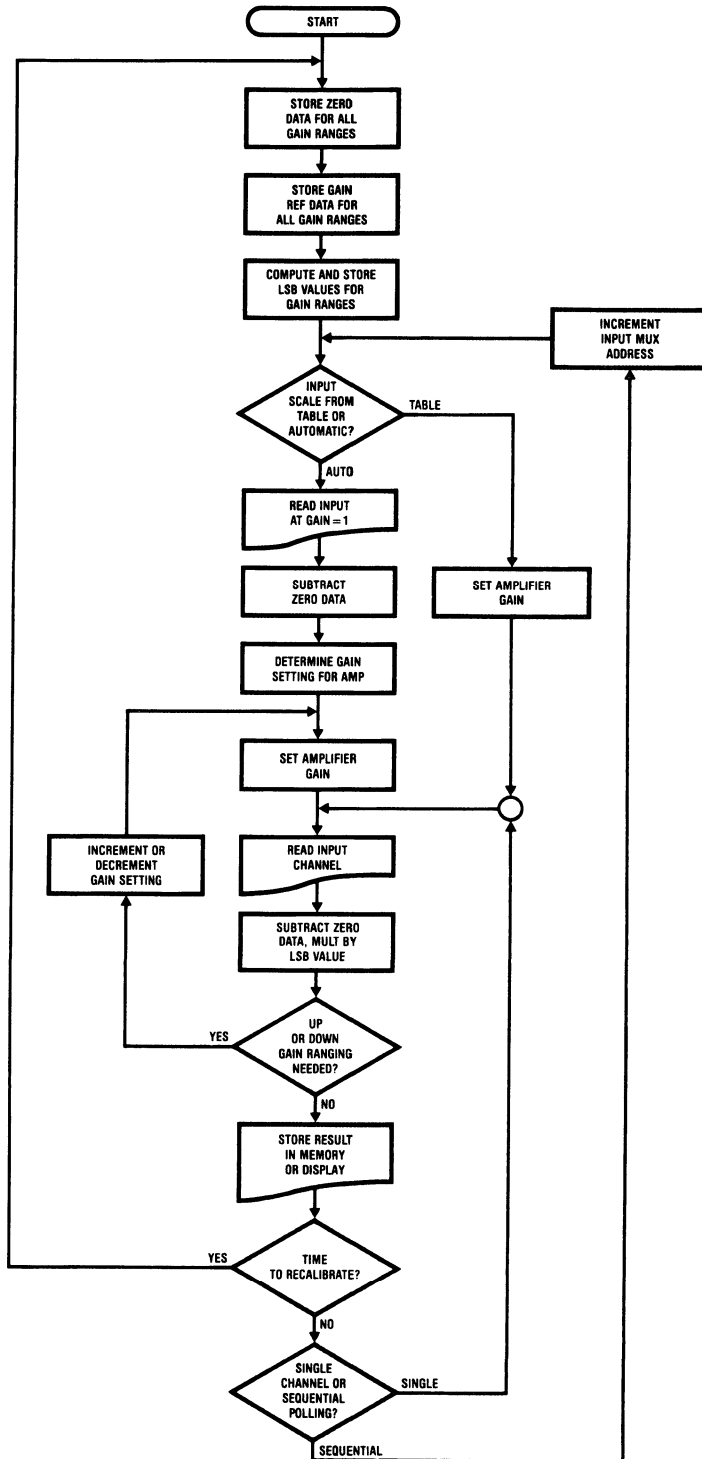


FIGURE 3. Flowchart of Auto-Calibration Auto-Scale Procedure

TL/K/6157-3

Figure 4 steps through an example calculation showing how the auto-zero and auto-scale correction works.

LSB Computation

Assume:

$$A_{V1} = 10.01 \quad A_{V2} = 0.992$$

(amplifier and S/H gain errors)

$$V_{OS1} = 5 \text{ mV} \quad V_{OS2} = 10 \text{ mV} \quad V_{OS3} = 7 \text{ mV}$$

(offset for each stage)

Reference voltage for $A_V = 10$ is 0.6986V

Full-scale range of ADC = 12V

Input voltage = 0.60V

Therefore: amplifier gain range = 10

Find Zero-Error Data

$$V_{IN} = \text{ground} = 0V$$

$$V_{O1} = A_{V1} V_{IN} + A_{V1} V_{OS1}$$

$$= (10.01)(0) + (10.01)(0.005) = 50.05 \text{ mV}$$

$$V_{O2} = A_{V2}(V_{O1} + V_{OS2})$$

$$= 0.992(50.05 \text{ mV} + 10 \text{ mV}) = 60.016 \text{ mV}$$

$$V_{ADC1} = V_{O2} + V_{OS3}$$

$$= 59.649 \text{ mV} + 7 \text{ mV} = 67.016 \text{ mV}$$

$$\text{Zero Data Decimal} = \frac{V_{ADC1}}{\text{ADC Full-Scale Range}}$$

$$= \frac{V_{ADC1}}{12V} 4096 \text{ bits} = \frac{67.016 \text{ mV}}{12V} 4096 \text{ bits}$$

$$= 23 \text{ bits (zero data correction factor)}$$

Find Gain Reference Data

$$V_{IN} = V_{REF1} = 0.6986V$$

$$V_{O1} = A_{V1} V_{IN} + A_{V1} V_{OS1}$$

$$= (10.01)(0.6986V) + (10.01)(5 \text{ mV}) = 7.043036V$$

$$V_{O2} = A_{V2}(V_{O1} + V_{OS2})$$

$$= 0.992(7.043036 + 10 \text{ mV}) = 6.9966117V$$

$$V_{ADC2} = V_{O2} + V_{OS3}$$

$$= 6.9966117V + 7 \text{ mV} = 7.0036117V$$

$$\text{Gain Reference Decimal} = \frac{V_{ADC2}}{12V} 4096 \text{ bits}$$

$$= \frac{7.0036117V}{12V} 4096 \text{ bits} = 2390 \text{ bits}$$

Compute LSB

$$1 \text{ LSB} = \frac{V_{REF10}}{\text{Gain Code} - \text{Zero Code}}$$

$$= \frac{0.6986V}{2390 \text{ bits} - 23 \text{ bits}} = 295.01698 \mu V$$

(scale correction factor)

Now Assume System Input = 0.6V

$$V_{IN} = 0.60V$$

$$V_{O1} = A_{V1} V_{IN} + A_{V1} V_{OS1}$$

$$= (10.01)(0.6) + (10.01)(0.005) = 6.05605V$$

$$V_{O2} = A_{V2}(V_{O1} + V_{OS2})$$

$$= 0.992(6.05605 + 10 \text{ mV}) = 6.01752V$$

$$V_{ADC3} = V_{O2} + V_{OS3} = 6.01752V + 7 \text{ mV}$$

$$= 6.02452V \text{ (reading includes errors)}$$

$$\text{Input Value Decimal} = \frac{6.02452V}{12V} 4096 \text{ bits} = 2056 \text{ bits}$$

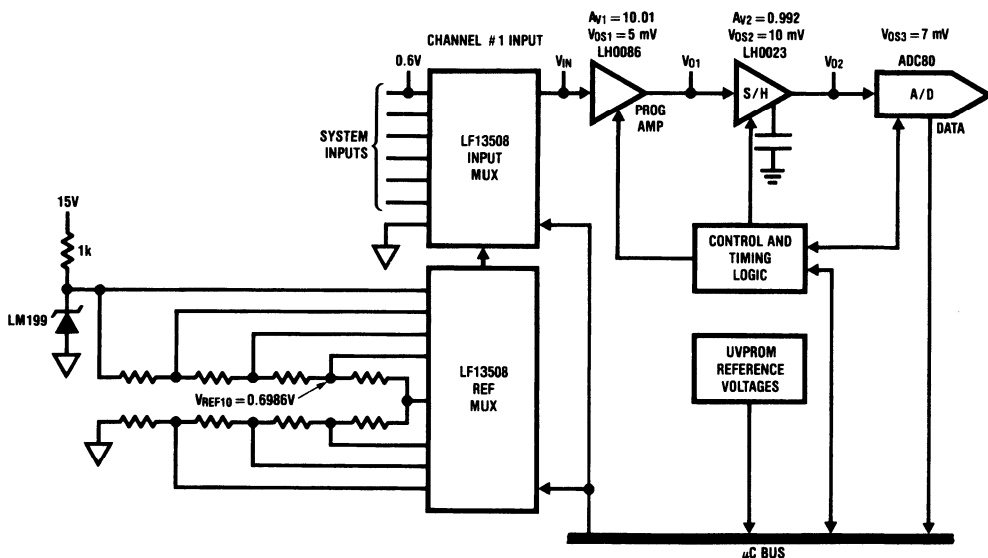


FIGURE 4. Typical Sequence of Auto-Zero, Auto-Gain Scale Correction

TL/K/6157-4

Now Subtract Zero Data from Input Code and Multiply by LSB Value

$$\begin{aligned}\text{True Input Value} &= (\text{Input Code} - \text{Zero Code}) \cdot (\text{LSB Value}) \\ &= (2056 \text{ bits} - 23 \text{ bits}) (295.01698 \mu\text{V}) \\ &= 0.60\text{V}\end{aligned}$$

Input Channel Polling

The next step depends on whether the software polls the input channels sequentially or individually. If it polls them sequentially, the input multiplexer address is incremented by one and the next channel is read. If not, the input remains addressed and the same numbers are used for offset and gain error corrections.

The calibration procedure should be repeated every few minutes or hours, depending upon environment and experience. This allows correction for any temperature drift effects in the components.

SYSTEM PERFORMANCE

System Performance Related to Input Range

Different ADC input ranges (unipolar, bipolar, etc.) have various effects on system performance. If a unipolar 0V–10V conversion is used, provision must be made for negative offsets in the system since 0V is the lowest reading possible. This can be accomplished by running the ADC in a bipolar connection with a –10V to +10V range, except that now an LSB is 4.88 mV instead of 2.44 mV, which results in an actual 11-bit resolution for a 0V to +10V input range. For this reason, a bipolar –2V to +10V range was chosen in this system. The –2V allows for negative offsets, while the 12V range increases an LSB to only 2.92 mV, thus preserving near 12-bit resolution. This input range scaling is accomplished on the ADC80 by inserting a 1 k Ω input scaling resistor in series with the internal 5 k Ω resistor. This forces the full-scale current of 2 mA to occur at $(2 \text{ mA}) \times (6 \text{ k}\Omega) = 12\text{V}$. The –2V offset is achieved by adding enough current at the summing junction of the comparator so that at a –2V input, the ADC thinks it is at zero scale. The necessary current is given by:

$$\frac{-2\text{V}}{6 \text{ k}\Omega} = -333 \mu\text{A}$$

An offset current of 333 μA is added via an 18.6 k Ω external resistor from the 6.2V reference output to the comparator negative input.

Temperature Effects of Reference Divider

Temperature coefficients of the external resistors need not match that of the resistors internal to the DAC because of the correction afforded by the auto-calibration operations. The same is true of the temperature coefficient of the offset current source.

However, temperature tracking within the reference resistor divider does affect system accuracy. The absolute accuracy of the resistor network is not of primary concern since the several divided output voltages are measured and stored in a UVPRM. Due to the LM199's long-term (1000 hours) stability of 20 ppm and low temperature coefficient of 0.5 ppm/ $^{\circ}\text{C}$ between –55 $^{\circ}\text{C}$ and +85 $^{\circ}\text{C}$, and 10 ppm/ $^{\circ}\text{C}$ between +85 $^{\circ}\text{C}$ and +125 $^{\circ}\text{C}$, the reference voltage itself will vary less than 90 ppm or 0.009% over 1000 hours and –55 $^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$, and only a maximum of 490 ppm or 0.049% over the entire –55 $^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$ temperature range.

Although the auto-calibration procedure corrects the ADC's gain and offset drifts, any tracking errors in the reference/divider network directly contribute to system accuracy error. This occurs because the LSB computation involves comparing the divided reference values to the values previously measured at 25 $^{\circ}\text{C}$ and stored in memory. Any change in the reference values will cause the LSB to think the system gain is higher (or lower) than it really is. The corrected result will then reflect this error.

If a thin-film resistor array were utilized, with careful layout procedures followed to keep temperature tracking within $\pm 1\%$, the total worst-case error would be ± 4.5 ppm/ $^{\circ}\text{C}$.

Noise Considerations

At high gains, the amount of noise present in the layout limits system accuracy. With an amplifier gain of 200, and the resulting full-scale input range of 50 mV, an equivalent LSB is:

$$\frac{50 \text{ mV}}{4096 \text{ bits}}$$

or 12 μV . Any noise above these levels will degrade system accuracy.

It is possible, however, to significantly reduce the noise component by taking several samples and averaging the readings. This is practical only in the event that the input signal is varying slowly compared to the conversion time.

The circuit layout, therefore, must be arranged to minimize noise. A single point analog ground is imperative. All analog ground connections, such as inputs, references, sampling capacitors, and supply bypassing are returned to this point. Separate analog and digital grounds must be provided to minimize coupling of digital noise into the analog circuits.

Digital signal traces should be kept as far as possible from the analog signal path to avoid capacitive coupling of signals. Both supplies on the ADC should be well bypassed close to the ADC.

Data Accuracy

The prototype system was tested over a -25°C to $+100^{\circ}\text{C}$ temperature range with DC signals between 5 mV and 10V to evaluate dynamic range and accuracy vs temperature.

Absolute accuracy of the system at 25°C was measured as better than $\pm 0.02\%$ for 10V full-scale inputs, and $\pm 0.08\%$ for inputs less than 50 mV. Over a -25°C to $+100^{\circ}\text{C}$ temperature range, accuracy decreased to $+0.035\%$ and $\pm 0.1\%$ for full-scale and low level inputs, respectively. This degradation was due to the total ± 3.2 ppm/ $^{\circ}\text{C}$ linearity tempco of the ADC and programmable-gain amplifier.

The $\pm 0.1\%$ accuracy figure measured at a gain of 200 represents accuracy to within ± 4 LSBs, which is impressive considering that an LSB is only $12\ \mu\text{V}$ at that gain range.

When system accuracy is represented as a percentage of full-scale range, % FSR, performance was better than $\pm 0.03\%$ ($G = 1$) and $\pm 0.07\%$ ($G = 200$) over the -25°C to $+100^{\circ}\text{C}$ temperature range. The accompanying graphs illustrate accuracy.

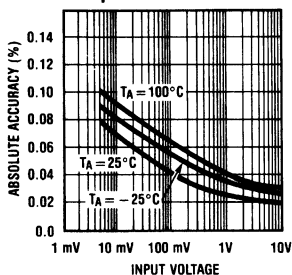
Operating speed was limited because the programs were written in Fortran; higher speed operation could be achieved by writing programs directly in assembly language. A conversion of an input channel without any auto-calibration or gain ranging took $350\ \mu\text{s}$, mainly computation time.

If a microprocessor such as the 8073 ($43\ \mu\text{s}$) or the NS16000 ($5\ \mu\text{s}$) with an internal multiply instruction were used, the same conversion could be performed in $250\ \mu\text{s}$ or $205\ \mu\text{s}$, respectively. By implementing some of the auto-calibration, gain ranging software procedures in hardware, the overhead time they add to the $350\ \mu\text{s}$ conversion could be further reduced.

CONCLUSION

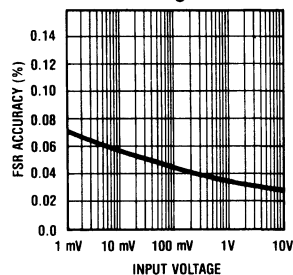
In this analog data acquisition system employing software implementation of error correction and gain ranging, the dynamic range improvements, flexibility and accuracy benefits are most useful in industrial control and instrumentation applications. Furthermore, the system requires neither calibration, potentiometers, nor periodic calibration adjustments.

System Absolute Accuracy vs Input Voltage and Temperature



TL/K/6157-5

System Accuracy, % FSR, Over -25°C to $+100^{\circ}\text{C}$ Range



TL/K/6157-6

An AM Radio I/C For Electronically Tuned Radios

National Semiconductor
Application Note 381
Martin Giles



INTRODUCTION

The LM1863 is an AM Radio I/C designed specifically to complement the LM1865 FM Radio I/C in high quality automotive electronically tuned radios. It features a high S/N ratio, low distortion and valid station stop detection, along with RF/IF AGC, high recovered audio output and low quiescent current drain. Also the design takes into account the future needs of AM stereo radios (irrespective of which system is the "winner") by providing a low phase noise oscillator, an IF amplifier output for stereo decoders, and a signal strength meter.

A major difference between the modern radio and previous automotive radios is the way in which the radio is tuned. Instead of variable air-dielectric capacitors (common in table radios) or variable inductors (slug tuned), the LM1863 is designed to work with varactor diodes. Because the control voltage developed by the tuning system is common to the antenna/RF stage as well as the L.O., tracking across the AM band can be tricky, particularly since the RF changes over a 3:1 range whereas the L.O. frequency changes over a 2:1 range. To ease this problem, a new RF input stage has been developed and the L.O. of the LM1863 is level controlled.

The RF stage is described in more detail later and it is sufficient to note here that an external discrete F.E.T. input stage is preferred over a bipolar I/C stage for overload

capability—a significant consideration for automobile radios that move around in the vicinity of a transmitter—and that the RF AGC developed by the LM1863 helps to prevent large signals appearing across the tuning varactors which would contribute to poor tracking and overload. Although the LM1863 can be used without an RF stage, i.e., a direct connection from the antenna to the mixer stage, for automotive applications it is necessary to isolate the RF tuned circuits from the highly capacitive whip antenna so that varactor tuning can be employed. This is achieved with the FET stage, and double-tuning provides a wide RF bandwidth for good audio quality yet with sufficient selectivity for good image (mirror signal) rejection.

Level control of the L.O. is important for good tracking performance, since the synthesized tuning system provides a tuning control voltage based on the bias required across the L.O. varactor for the desired station frequency. If the amplitude of the L.O. waveform modulates the varactor capacitance differently at each end of the band, then slightly different dc tuning voltages will be developed which will tend to skew the RF tuning. The L.O. output is also buffered for the tuning synthesizer phase detector input (for more information on the synthesized tuning I/Cs, see AN-335 and the DS8906/07/08/09/10 data sheets).

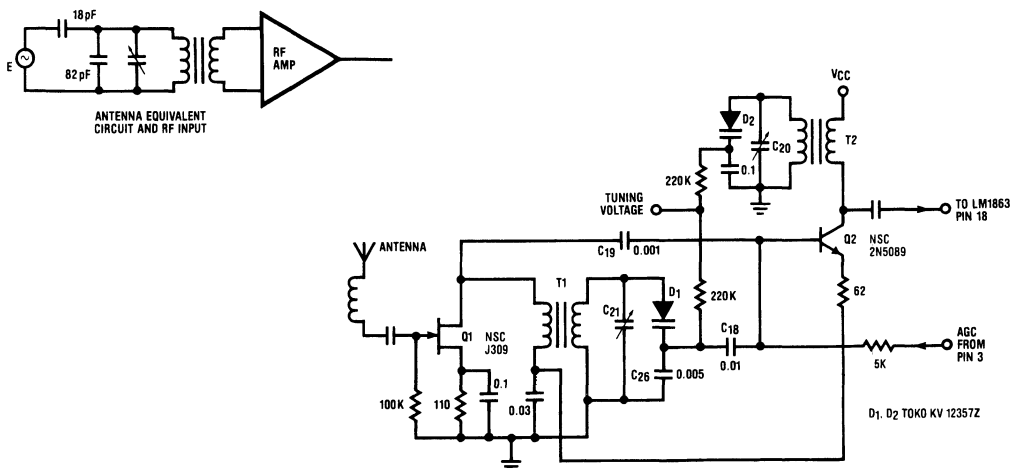
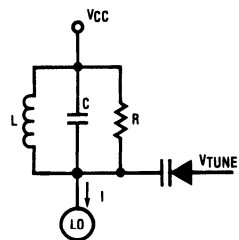


FIGURE 1. Improved R.F. Stage

TL/H/8366-1



$$QL = \frac{R_P}{\omega} = \text{CONSTANT}$$

TL/H/8366-2

$$R_P \Big|_{2\text{MHz}} = 2 \times R_P \Big|_{1\text{MHz}}$$

$F_{IF} = F_{LO} - F_{RF}$	
RF TUNING RANGE (kHz)	LO TUNING RANGE (kHz)
505 - 1638	955 - 2088
$\frac{F_{HIGH}}{F_{LOW}}$ 3.2:1	$\frac{F_{HIGH}}{F_{LOW}}$ 2.2:1

FIGURE 2. Change in LO Amplitude with Frequency

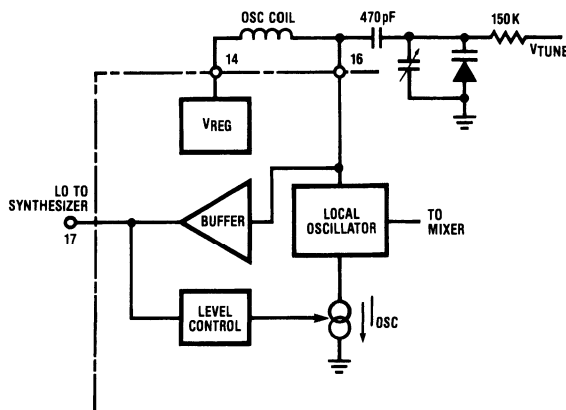
RF AGC is obtained directly from the signal amplitude at input to the mixer stage. Since this is before the IF amplifier selectivity, the RF AGC is wideband so that when strong interfering signals are present within the RF bandwidth, gain reduction will help to prevent intermodulation products from being developed and masking the desired signal. Even so, the threshold at which AGC action begins must be high enough to prevent loss of signal sensitivity due to premature RF AGC. Because the threshold is set internally to 6 mVrms at the mixer input, changing the RF stage gain will have the effect of changing the antenna RF AGC threshold. Prior to RF AGC action both the mixer and the IF amplifier are gain reduced by up to 20 dB to maintain a good S/N ratio with high sensitivity for the entire system. A 20 dB S/N ratio is obtained for only 30 μV RF input levels (through a -16 dB equivalent antenna pad), and a maximum S/N ratio of 54 dB is obtained at strong RF signal levels. The mixer gain is adjusted by a tap on the mixer output coil which is also providing an impedance match to the IF ceramic filter. The IF gain is similarly set by the L-C-R tank circuit connected to the IF output. This is the point at which a phase modulated IF carrier is obtained for a stereo decoder.

Returning to the L.O. for the moment, when a phase modulated signal is received, any phase variation in the L.O. waveform will be transferred to the IF waveform and be detected in the PM channel of the stereo decoder. This means

poor stereo separation and degraded S/N ratios. The impact of L.O. phase noise is further aggravated by the relatively limited deviation employed in the proposed stereo systems which is typically 1 radian maximum (or practical). The LM1863 L.O. has been designed for low phase noise although the varactor control voltage and associated resistor will tend to reduce the noise performance. Currently we are observing around 60 dB S/N for the LM1863 L.O. alone, decreasing by 6 dB to 10 dB when varactor control is applied.

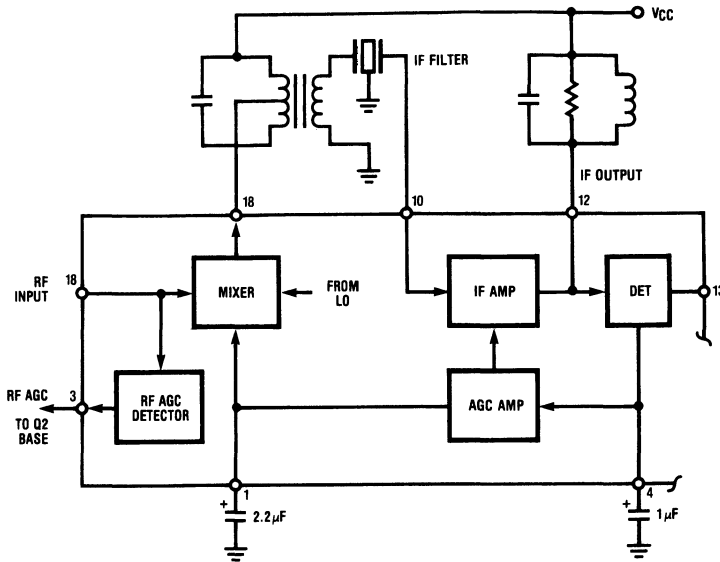
For automatic stopping on valid stations, the LM1863 measures the signal strength (is the station S/N ratio good enough?) and looks to see if the IF carrier is correct (a 455 kHz waveform from the IF amplifier output?). The signal strength indication is obtained simply from the IF/Mixer AGC amplifier which also provides a signal strength meter output drive. The presence of the correct IF waveform is determined by applying the IF amplifier output to a limiter stage followed by an inexpensive 455 kHz ceramic filter. In the case of a stereo radio, this IF carrier presence could also be detected from the excess phase output of the stereo decoder (see LM1981/CLAU 124B).

Damping the resonator with an external resistor will increase the "window" for frequencies that can activate the stop detector and another resistor will set the signal strength threshold level required for stop indication.



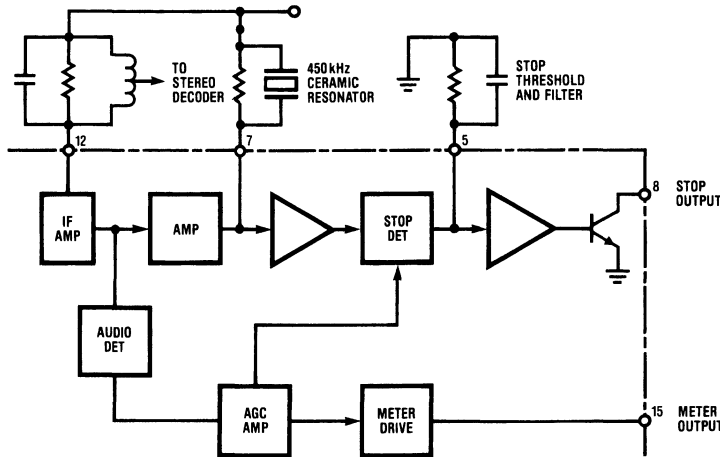
TL/H/8366-3

FIGURE 3. Level-Controlled Local Oscillator



TL/H/8366-4

FIGURE 4. Mixer IF Amplifier and AGC Stages



TL/H/8366-5

FIGURE 5. Automatic Station Stop Detector

Automatic scanning for valid stations is fine as long as it doesn't take too long to identify a station. However, in order to detect the signal strength when the scanner moves from a strong station to a weaker station requires rapid AGC settling. This leads to problems with audio distortion since the AGC detectors for an AM waveform are supposed to track only the average envelope amplitude. If fast AGC action is required, there is a tendency to start tracking the modulation

envelope thus causing detected audio distortion. The LM1863 minimizes this effect yet obtains faster AGC settling by using dual time-constant AGC filters.

Typical performance characteristics are summarized in Table I and Figure 6 shows a complete block diagram of the LM1863. With this overview of the design goals and circuit functions of the LM1863, we can now turn to a more detailed description of the actual I/C.

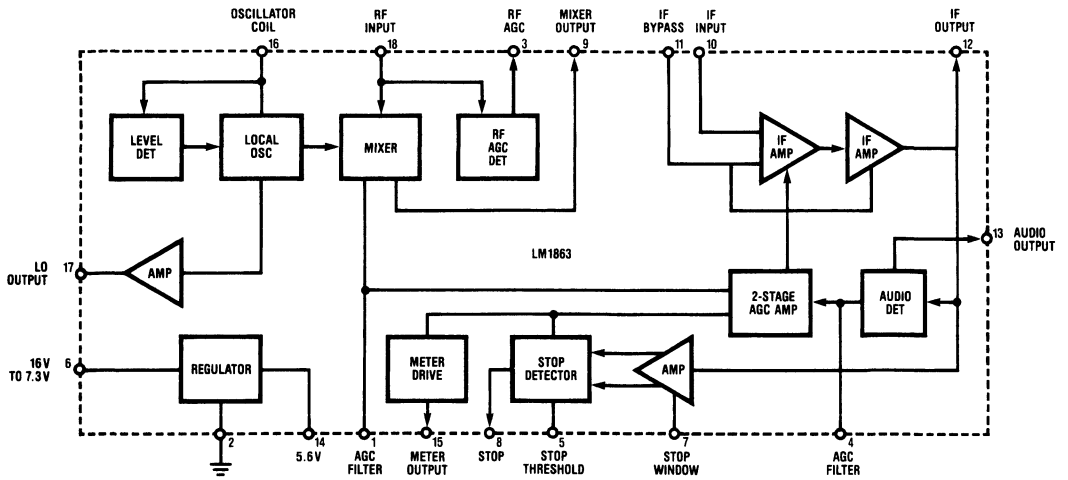


FIGURE 6. LM1863 Complete Block Diagram

TL/H/8366-6

TABLE I. Performance Summary

Static Characteristics

Supply Current	8.2 mA
Operating Voltage	7.0–16V

Dynamic Characteristics

$$f_{\text{MOD}} = 1 \text{ kHz}, f_o = 1.0 \text{ MHz } 30\% \text{ MOD}$$

Maximum Sensitivity	2.2 μV
20 dB Quieting	30 μV^*
S/N (10 mV Input)	54 dB
THD	0.2%
Audio Output	125 mV
Stop Signal Threshold	50 μV^{**}
Stop "Window"	4 kHz
Stop Time	<50 ms
RF Bandwidth	28 kHz
Image Rejection	>70 dB
RF AGC Threshold	3 mV*

*with 16 dB Antenna Pad

**Externally Adjustable

THE R.F. AMPLIFIER STAGE

A schematic for the RF stage is shown in *Figure 1* and consists of an FET front end which is able to isolate the antenna capacitance from the tuning varactor diodes and withstand the potentially high signal field strengths that may be present. Since the FET transfer characteristic is basically square law, this means better intermodulation performance is obtained compared to a bipolar input stage, particularly at lower operating current levels. Two tuned circuits at the input and the output of the second stage transistor Q_2 can be adjusted to give a good RF bandwidth for signal fidelity, yet adequately reject image frequencies that can appear at the antenna. Also the coupling between Q_1 and Q_2 has been arranged to compensate for the increasing gain that occurs as the frequency goes up because of the increase in dynamic impedance of the tuned circuits. The main signal path is through C_{19} into the base of Q_2 . At the low end of the AM band, the tuning varactor D_1 and the capacitor C_{26} act as a divider, supplying an additional signal path through C_{18} to Q_2 base. As the tuned radio frequency increases, the capacitance of D_1 decreases and less signal is coupled through C_{18} , thereby keeping the RF gain relatively constant across the band.

If the RF stage gain was maintained throughout the operating signal strength range of the radio, high RF signal levels would cause modulation of the tuning varactors and overload of the mixer stage, resulting in crossmodulation and tweet problems. To prevent this, above a certain RF threshold level, Pin 3 of the LM1863 pulls current through the 5 k Ω resistor also connected to Q_2 base. Since the dc bias for Q_1

is supplied through Q_2 and T_1 primary, when Q_2 base is pulled down it forces Q_1 to operate in its low gain resistive region.

THE LOCAL OSCILLATOR

The basic L.O. circuit is comprised of the differential pairs Q_3Q_4 and Q_5Q_6 providing gain, and positive feedback from an L/C frequency determining network through Q_{1A} and D_1 . Q_{15} buffers the L.O. with an output level of 147 mVrms at Pin 17 for the frequency synthesizer system, and drives the level detector circuit of Q_9 and C_1 . This in turn controls the gain of Q_5Q_6 through the current source $Q_7Q_8Q_{12}$ (*Figure 7*).

The relative complexity of the oscillator circuit is determined by the need for a stable oscillator frequency and low phase noise. Addressing stability first, with an external L/C tank circuit setting the operating frequency, it is desirable to keep the tank circuit Q as high as possible. With a high Q, any drift in internal phase shift of the oscillator because of temperature or supply voltage changes will require only a small shift in the frequency to compensate. Of course, for a synthesizer system the tuning control voltage will change by a small amount instead, so that the operating frequency remains constant. The disadvantage of high Q operation is that the oscillator output load is set entirely by the dynamic impedance of the tank circuit. For a fixed peak current from the oscillator, this means that the output amplitude will change with operating frequency and cause modulation of the varactor diode that is used in place of the tuning capacitor C shown in *Figure 7*.

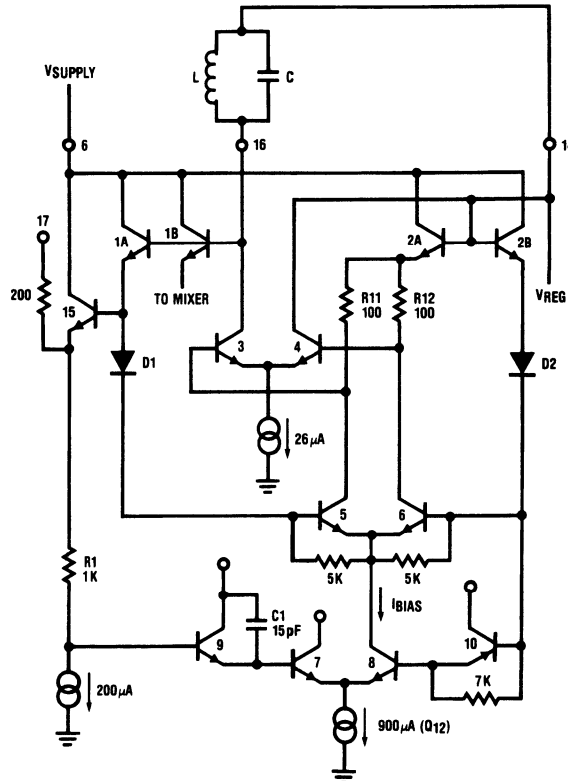


FIGURE 7. Low Noise Amplitude Controlled Oscillator

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The LM1863 solves the problem of working with a high Q tank circuit by controlling the oscillator amplitude. The tank circuit voltage is detected and, above a certain threshold level, dc feedback controls the circuit gain for a constant amplitude waveform. The threshold level is set at 147 mVrms — a signal level that is sufficiently large to ensure full switching of the mixer stage and adequate drive to the frequency synthesizer, yet not large enough to cause forward biasing of the tuning varactor when low tuning control voltages are being applied. The minimum control voltage on the varactor is about 1V, and if the ac signal swing caused forward biasing, the varactor Q would fall and cause it to load the oscillator output.

The oscillation threshold level is set by a 200 μ A current flowing through R₁, which gives a 200 mV offset across the differential pair Q₇Q₈. As a result most of the current in Q₁₂ is flowing through Q₈ and in the differential pair Q₅Q₆. This is the maximum gain condition for this stage. When the peak positive swing of the oscillator waveform exceeds 200 mV peak, the capacitor C₁ is charged, and Q₇ takes more of the current available from Q₈, thus reducing I_{BIAS} and the Q₅Q₆ stage gain correspondingly. Since the following stage Q₃Q₄ gain is fixed by the tank circuit load resistance and an internal 26 μ A current source, the I_{BIAS} at which oscillation amplitude becomes constant is given by

$$I_{BIAS}(mA) = \frac{83.3}{R_p} \quad (1)$$

As the tank circuit load impedance is reduced, the oscillator amplitude will drop slightly due to finite loop gain in the feedback path, but load resistors as low as 30 k Ω can be accommodated with the range of I_{BIAS} provided in the oscillator circuit.

To keep phase noise to a minimum, the DC output current from Q₃ is kept low and both base drive resistors R₁₁ and R₁₂ are small. The base ac signal drive is also small to prevent signal rectification occurring in the emitters of Q₃Q₄

as a result of the low tail current. If rectification were allowed to happen the oscillator waveform would be phase shifted by the generation of a 2nd harmonic. Although Q₅Q₆ are being driven hard enough to be switched, the relatively heavy I_{BIAS} current level will prevent rectification, even when I_{BIAS} is varied to control the amplitude. The noise current contribution of I_{BIAS} appears as a common-mode signal to the output stage Q₃Q₄, ensuring good overall low noise operation.

THE MIXER AND RF AGC DETECTOR

The mixer is the familiar, doubly balanced monolithic type which suppresses both the incoming RF and LO waveforms in the output, enabling low cost ceramic filters to be used in the IF amplifier.

The conversion gain of the mixer is determined by the load impedance of Pin 9 and the transconductance of the lower transistor pair Q₂₀Q₂₁ and the diodes D₃D₄. Q₂₂ controls the current flowing in this stage and by changing this current level, the mixer can be AGC'd. At maximum gain, the total current is 1 mA, yielding a mixer gain of

$$A_v = \frac{R_L}{\pi \times 104} \quad (2)$$

The load for the mixer also provides the impedance match to the ceramic filter that is setting the main selectivity characteristic of the IF amplifier. Even so, these low cost filters do not completely satisfy the typical radio selectivity requirements. Usually the adjacent channel attenuation is only around 20 dB, and the spurious response rejection barely 27 to 30 dB. To improve the A.C.A. and spurious response, the mixer tank circuit and the IF output tank also contribute to the radio selectivity.

For a typical I.F. transformer, the capacitor included within the shield is constrained by economic and manufacturing considerations to 180 pF or less. This relatively small capacitor size has two impacts. The necessarily large induc-

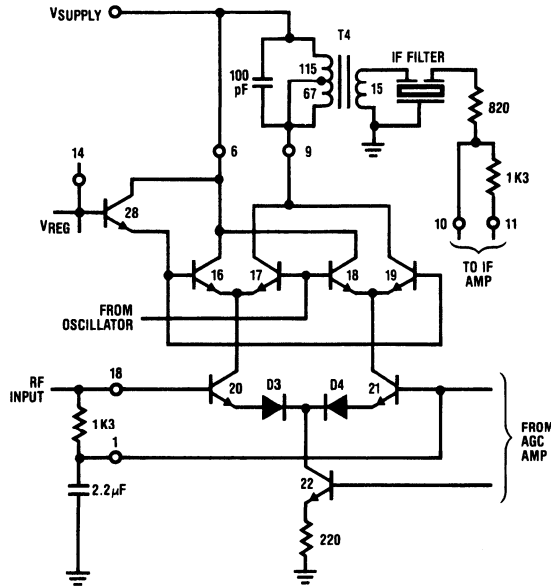


FIGURE 8. Doubly Balanced Mixer

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tance required for tuned operation at 450 kHz means that unloaded Q values range between 90 and 150, so that operation at or close to the unloaded Q is desirable — high insertion loss is inevitable. Secondly, any variation in the mixer amplifier output capacitance with supply voltage changes will have the effect of detuning the tank circuit. For example, if the total tuning capacitance is 100 pF, then a capacitance change of < 1 pF (roughly the change that will occur in the LM1863 mixer output over the operating supply voltage range) will detune the tank circuit by 2.2 kHz! Fortunately both problems can be solved by tapping the primary coil of the transformer. This reduces the loading effect of the mixer output impedance on the tuned circuit and isolates the potential variation in output capacitance.

Putting a few numbers to the mixer output circuit shown in Figure 8, the coil primary is specified for an unloaded Q of 100 and tunes to 450 kHz with a 100 pF capacitor. With a primary tap ratio of 2.72:1 the maximum change in capacitance across the coil is now < 0.14 pF, causing less than 300 Hz detuning effect. The reflected load across the primary from the mixer output is $200 \times 10^3 \times (2.72)^2 = 1.5 \text{ M}\Omega$. With a primary inductance of 1.25 mH, the tank dynamic impedance is 350 k Ω which gives a total load resistance of 283 k Ω and a working Q of 89. Therefore the turns ratio required to match the 2 k Ω input impedance of the ceramic filter is 11.9:1. Practically, 12:1 is used, giving the number of turns on the secondary as 15. The primary of the transformer reflects a load to the mixer output of $283 \times 10^3 / (2.72)^2$, or 38.25 k Ω , setting the maximum gain from the mixer input to across the primary of

$$A_V = \frac{38.25 \times 10^3}{\pi \times 104} \times 2.72 = 50 \text{ dB}$$

The transformer voltage loss is 21.6 dB and the ceramic filter insertion loss is typically 1 dB to 6 dB. Together with the resistive divider loss of 4.3 dB at the input to the IF, total circuit losses amount to 27 dB, giving an overall gain (mixer input to IF input) of 23 dB. More or less gain can be accommodated by shifting the tap on the mixer coil or revising the resistive divider at the input to the IF amplifier. However, this value of gain has been chosen in conjunction with the gain provided by the other active circuits to optimize the radio sensitivity and signal handling capability. Care should be exercised when other gains or operating bandwidths are selected.

To maintain low distortion at large input signal field strengths, the mixer input level is limited to 6 mVrms. Until the mixer input reaches 6 mVrms, the mixer and IF amplifier are both gain controlled, with the RF stage operating at full gain to give high sensitivity and good S/N ratios. After 6 mVrms has been reached, the wideband AGC detector Q_{23} through Q_{30} comes into operation and begins to gain reduce the RF stage. Wide-band AGC refers to the fact that the AGC detector is responding to all sufficiently large input signals within the RF bandwidth. Thus a strong adjacent signal capable of producing cross-modulation in the RF/mixer stages is detected, whereas a conventional narrow-band detector (following the audio detector stage) would not sense the presence of such a signal, since it would be outside the IF amplifier bandwidth. The threshold level is set by the difference in collector load resistors of Q_{23} and Q_{24} . For no signal input, the collector of Q_{24} is 250 mV below Q_{23} collector, thus completely off-setting Q_{26} , Q_{27} . For Q_{26} to begin sourcing current this offset must be reduced by the signal level at Pin 18 to between 60 mV and 70 mV. Then the output device Q_{30} starts to sink current — 10 μA for a 6 mVrms, 30% modulated input signal. As the signal increas-

es, Q_{30} sinks more current, pulling down the base of Q_2 in the RF stage and reducing the RF gain. Higher modulation depths (contributing to more cross-modulation from unwanted carriers) tend to reduce the RF AGC threshold slightly — to about 5.3 mVrms at 80% modulation.

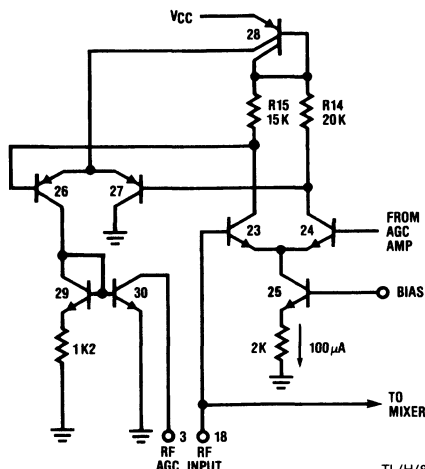


FIGURE 9. RF AGC Detector

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THE I.F. AMPLIFIER

A two stage amplifier is used for the IF waveform. The first stage is a differential pair $Q_{53}Q_{54}$ with a 1 mA tail current source Q_{51} . With this current the stage gain is almost 28 dB, and the signal is dc coupled to the output through the second stage Q_{56} . Since the output load for Q_{56} is external and set by the IF tank circuit tuned impedance R_L , the total IF amplifier gain is given by

$$A_V = 28 \text{ dB} + 20 \log_{10} \frac{R_L}{108} \text{ dB} \quad (3)$$

At 450 kHz the tank dynamic impedance is 354 k Ω which, in parallel with a damping resistor of 200 k Ω to give an operating bandwidth of $\pm 3.5 \text{ kHz}$ ($Q_L = 64$), transfers a total load of 3 k Ω to Pin 12. Therefore the total IF amplifier gain is 28 dB + 29 dB = 57 dB.

The I.F. amplifier gain can be changed in two ways; either by AGC action as described later, or by changing the load impedance at the second stage output, Pin 12. However, in order to preserve signal handling capability the IF amplifier maximum gain should not be allowed to fall below approximately 50 dB. This is because the AGC system will be holding the output constant and a lower gain amplifier will mean larger input signals that may overdrive the input stage, causing distortion. For example, an 80% modulated signal will swing 2.5 volts (p-p) at the output. If the amplifier maximum gain is 50 dB, after 20 dB IF gain reduction the input signal level is 28 mVrms, which is uncomfortably close to the maximum recommended input level of 50 mVrms.

Automatic Gain Control of the IF amplifier is obtained by offsetting the differential pair $Q_{51}Q_{52}$. At maximum gain the total current for $Q_{53}Q_{54}$ flows through Q_{51} . As AGC action commences, the current flow is shifted over to Q_{52} as Q_{49} pulls down Q_{51} base. When this happens the stage gain is reduced by the emitter degenerating resistors R_{41} and R_{42} . These resistors are slightly different in value so that the dc output level on Q_{56} base is kept constant as the current shifts from Q_{51} to Q_{52} , preventing the possibility of Q_{56}

collector saturating on large signal swings. Connecting the IF coil to the higher supply voltage rather than VREG is not permitted since dc coupling is employed between Pin 12 and the audio detector stage.

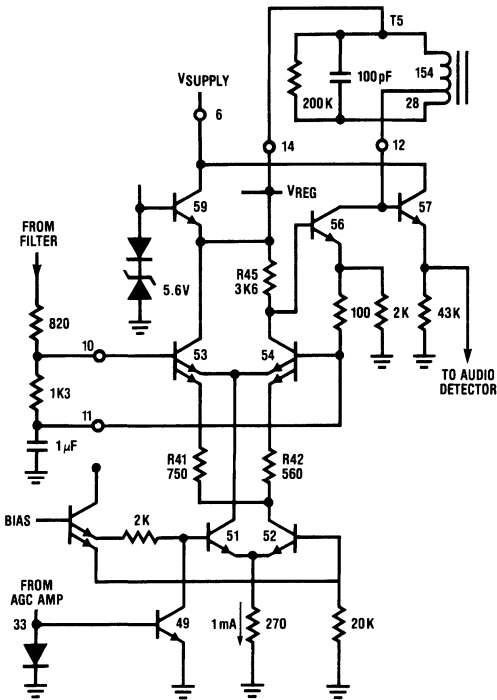


FIGURE 10. Two Stage IF Amplifier

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THE DETECTOR AND AGC AMPLIFIERS

Transistor Q57 buffers the IF amplifier output from the internal envelope detector Q60. C2 and the recovered audio passes to Pin 13 through the emitter followers Q61Q62. For any diode envelope detector, the RC time constant (constituted by the capacitor C2 and the load presented by Q61) is a compromise between providing adequate filtering of the I.F. waveform from the output, and preventing slewing distortion. If the time constant is too long (more effective filtering), then at high modulation indices and modulating frequencies the capacitor will not be discharged fast enough to track the downward modulation of the signal. This causes slewing distortion or "diagonal clipping" and to avoid this

$$RC < \frac{1}{\omega_m} \left(\frac{1}{M_2} - 1 \right)^{1/2} \quad (4)$$

For the LM1863, $RC \sim 1.13 \times 10^{-4}$, which means that at 80% modulation depth, frequencies up to 1 kHz will be free of diagonal clipping.

The detected audio also drives the AGC amplifiers through the buffer transistor Q61. The first amplifier Q66Q67Q68 is offset by R52 and this resistor is large to provide sufficient emitter degeneration so that the amplifier can handle the large amplitude signals that will be present by the time that the AGC threshold is reached. The reason for this is that the amplifier must linearly amplify the signal prior to AGC action for the meter drive and stop detection circuits.

As the detected signal level increases, the current in Q68 is mirrored in Q69 and passes to the second AGC amplifier Q35Q36Q37Q38. At this point the signal is filtered in two places.

First, at the base of Q69 with a time constant set by the internal resistor, R56, and an external capacitor C4 at Pin 4. This sets the AGC loop high frequency pole. Secondly, a dominant or low frequency pole is set by an external capacitor, C5, at Pin 1, working against the feedback impedance of the second AGC amplifier. The first higher frequency pole

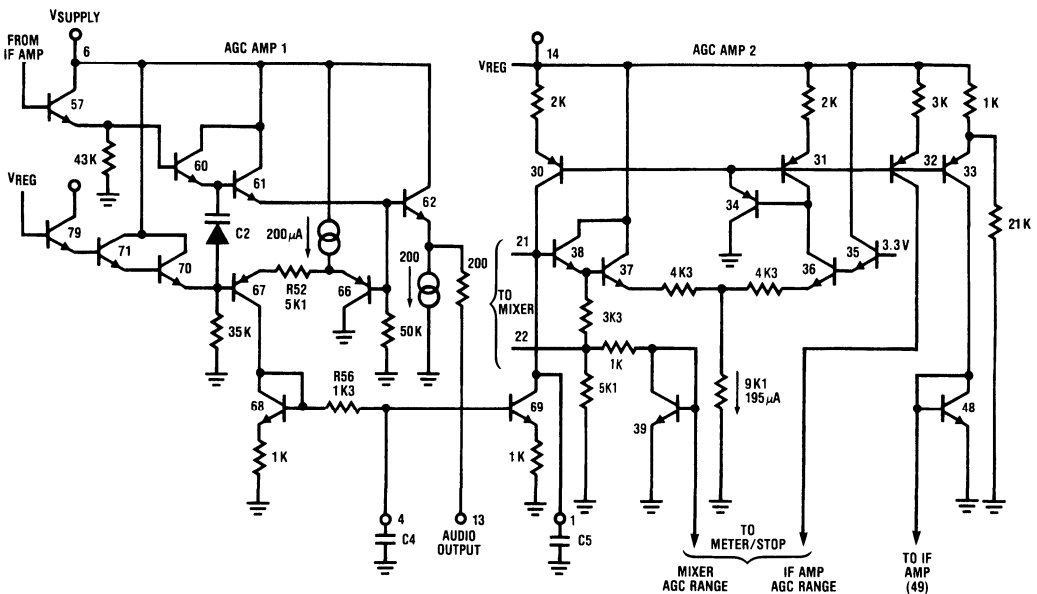


FIGURE 11. Detector Stage and AGC Amplifiers

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allows C_5 to be much smaller than that required for a single pole loop with equivalent THD, and a smaller capacitor means that faster stop times are obtained. C_5 is selected empirically for the desired stop indication time under specified signal conditions (typically less than 50 ms) and C_4 is chosen to minimize the THD. Since both capacitors will affect the THD and stop time an iterative selection process is indicated. A couple of precautions are worth noting; a large ratio between the capacitors will either degrade the stop time or THD, or too small a ratio will cause peaking in the loop response, producing low frequency noise in the audio output.

As the detected signal increases, more current flows in Q_{69} collector. This is supplied by Q_{30} which is a mirror to the current change in Q_{36} as $Q_{38}Q_{37}$ base voltages start to fall. Q_{36} current is also mirrored by Q_{32} for the stop detector and meter drive circuits. Above a given threshold, further increases in signal level will cause Q_{33} to conduct and the IF amplifier begins to gain reduce. The overall AGC loop gain is relatively low and the detected audio continues to increase while the IF amplifier gain is reduced by about 20 dB. Q_{30} current cannot continue to increase after this point is reached because it is limited to the maximum total current available to $Q_{36}Q_{37}$. Now the base voltage of Q_{38} will start to fall rapidly. This pulls down the base of the IF mixer device Q_{22} , which gain reduces the mixer. Small changes in Q_{22} base voltage will produce large changes in device gain and the increased AGC loop gain now holds the detector output level constant until gain reduction is taken over by the RF stage. Figure 12 shows the gain reduction of the IF and mixer as the signal strength increases.

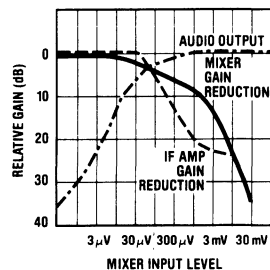


FIGURE 12

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STOP DETECTOR AND METER DRIVE

Prior to any AGC action the current from the AGC amplifiers is applied to the stop detection circuit and to the meter drive circuit. Initially the AGC current from Q_{32} flows into the diode Q_{80} and is mirrored yet again in Q_{89} and Q_{88} before being converted to a voltage across the internal 50 kΩ resistor R_{60} . Q_{90} buffers the meter output voltage to Pin 15. As the signal level continues to increase, Q_{33} turns on and the IF amplifier is gain reduced. When Q_{32} and Q_{33} can no longer increase in current level, the gain reduction transfers to the mixer as the base voltage of Q_{38} falls. Simultaneously the current in R_{19} decreases, removing the offset across Q_{41} and Q_{42} . Originally Q_{42} was taking all the tail current from R_{32} but when Q_{41} turns on more current is sourced to Q_{80} , continuing the increase in meter voltage throughout the mixer AGC range.

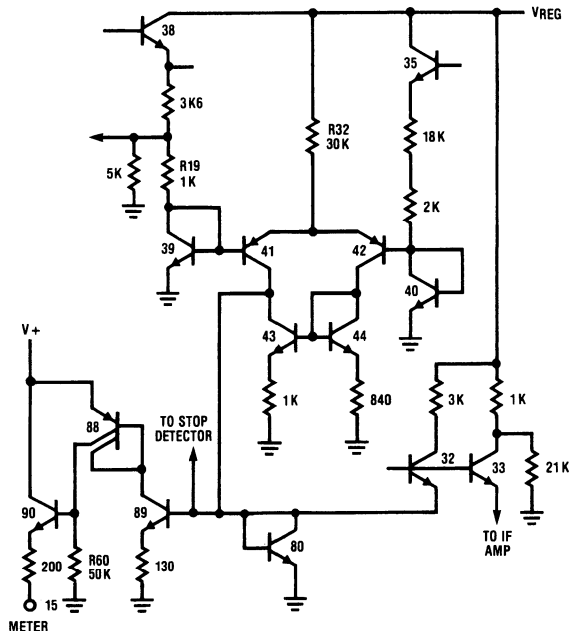


FIGURE 13. Meter Drive Circuit

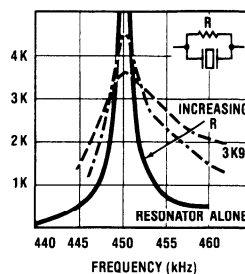
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Similarly, the current sourced to Q_{80} as the signal level increases is also appearing in Q_{81} , thus supplying an increasing tail current to the differential pair $Q_{82}Q_{83}$. Therefore, for a given bias voltage across this pair, more current will be available to Q_{84} . The bias across $Q_{82}Q_{83}$ is determined by the presence or absence of an IF amplifier output at the proper frequency. Spurious signals not at the intermediate frequency will cause the current in Q_{81} to increase but unless the offset is removed from $Q_{82}Q_{83}$ this current is dumped into the supply and there will be no stop indication.

The IF signal is coupled directly to the differential pair $Q_{75}Q_{76}$ with the collector of Q_{75} connected over to Q_{93} base. The collector of Q_{75} is also connected to a piezo-ceramic resonator at Pin 7. This resonator has a shunt resistor across it causing a small decrease in Q_{75} collector voltage, thus offsetting $Q_{92}Q_{93}$ (and subsequently $Q_{82}Q_{83}$) under no-signal or mistuned conditions. However, when an ac signal is present within the bandwidth of the resonator, this signal is coupled to $Q_{92}Q_{93}$ which provides a differential 450 kHz signal to the stop detector $Q_{82}Q_{83}$. Rectification of the ac signal by Q_{85} and C_3 , along with a signal strength causing sufficient current flow in Q_{81} , provides a stop indication at Pin 15. The signal strength at which this occurs can be adjusted by the external resistor at Pin 5. Because of the somewhat limited gain available in the resonator amplifier (to prevent large unbalanced currents at harmonics of the intermediate frequency—which can contribute to tweet) large modulation peaks will create glitches in the stop detector output. The filter capacitor across the resistor at Pin 5 will help prevent these glitches, but the time constant must be kept under 30 msec, to avoid increasing the stop time required during the station scanning mode. Pre-charging the

capacitor with an external 1.2 M Ω resistor from the supply allows a longer TC to be used without affecting the stop time. Adjusting the range of signals passed by the resonator is done by changing the damping resistor across the resonator. Some bandwidth increase is necessary since the center frequency is specified only to within ± 1 kHz of the correct frequency. Nevertheless, too much damping should not be used if response to adjacent channels is to be avoided.

Other alternatives to using a resonator for determining the IF amplifier output frequency are possible. Some synthesizer systems include a counter for the IF and the excess phase output from a stereo decoder 1/C (such as the LM1981) will also provide an indication of the correct IF. In these cases, Pin 7 of the LM1863 is connected to the regulator voltage at Pin 14 so that now Pin 5 simply responds to the signal strength.



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FIGURE 15. Ceramic Resonator Characteristic

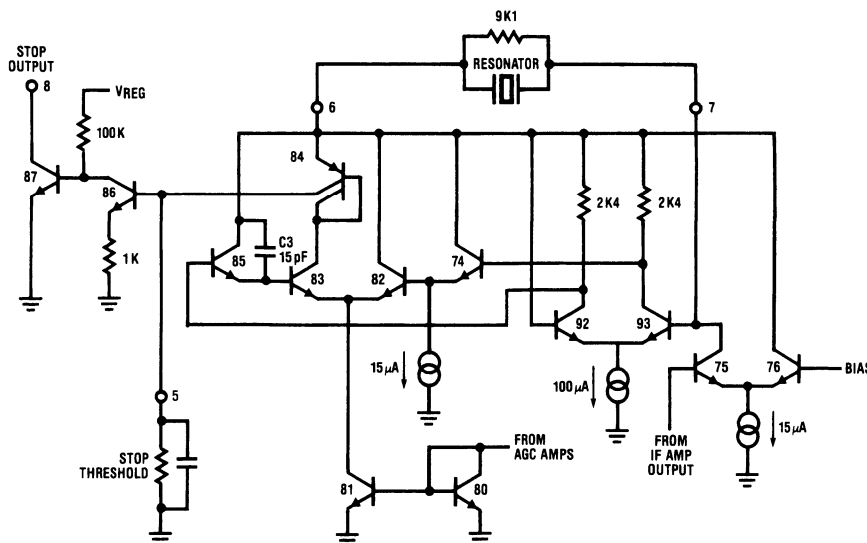


FIGURE 14. Valid Station Stop Detector

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A complete AM radio design is shown in Figure 16 with an appropriate p.c.b. layout in Figure 17. The dashed lines from the gate of Q₁ and Pin 18 of the LM1863 represent the different connections required for evaluation/measurement purposes or for use as a radio.

In order to align the mixer/IF amplifier stages, inject a 10 mVrms, 1 MHz carrier waveform through C₂₃ to the mixer input. Set the LM1863 L.O. exactly to 1.45 Mhz (measured at Pin 17) by adjusting the tuning voltage on the varactor diode D₃ — the positive terminal of capacitor C₂₅ on the p.c.b. When the correct tuning voltage is reached, approximately 4.5V DC, the IF output frequency at Pin 12 will be

450 kHz. Reduce the carrier level to 10 μ Vrms and modulate to a depth of 30% with a 1 kHz audio signal. Peak T₄ and T₅ until the recovered audio at Pin 13 reaches a maximum. If necessary, adjust T₅ slightly until the THD is less than 0.5% when the modulated carrier level is increased back to 10 mVrms.

For RF alignment, reset the tuning voltage to 1V DC and center all the trimmer capacitors. Adjust the L.O. coil for a frequency of 980 kHz at Pin 17 and then increase the tuning voltage until the output frequency is 2060 kHz. The required tuning voltage should be between 7.5V DC and 9.5V DC or readjustment of the coil and trimmer capacitor C₂₄ is need-

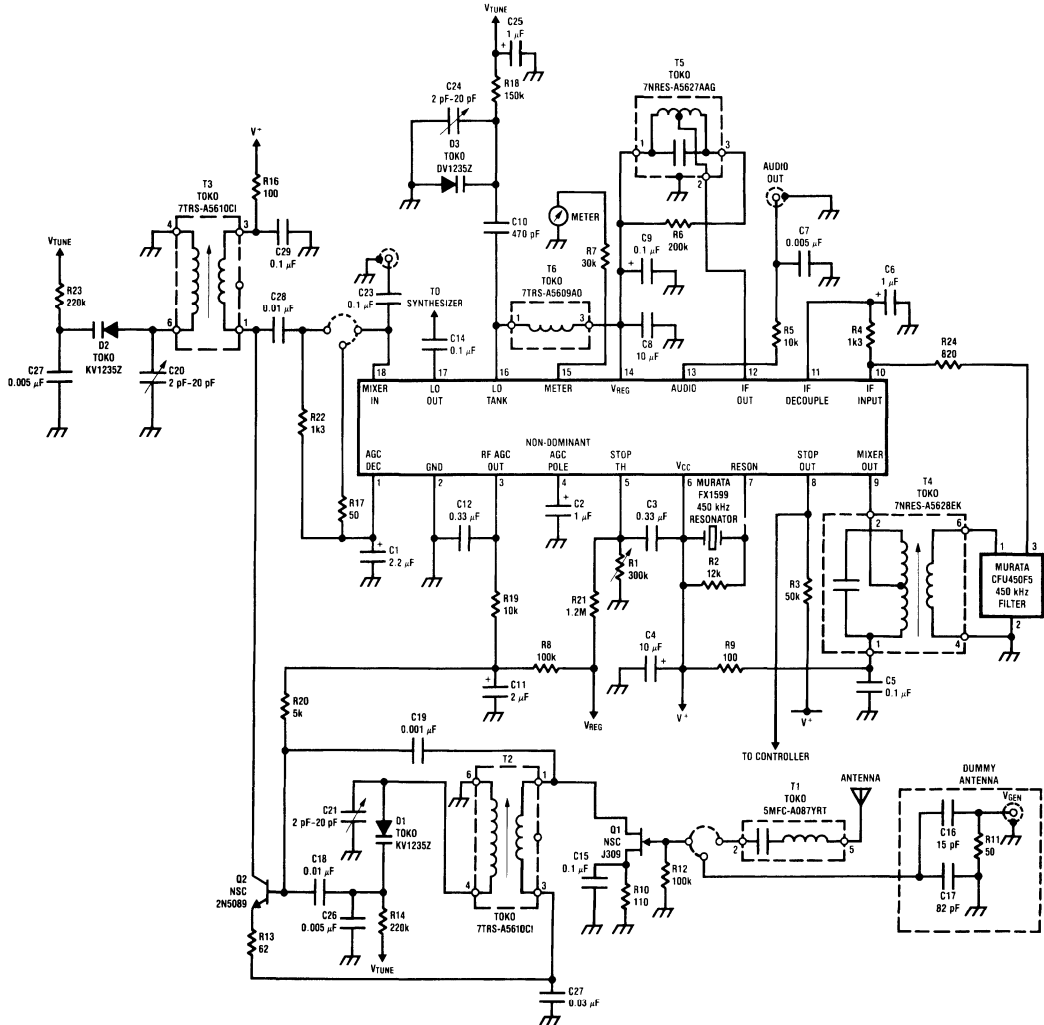
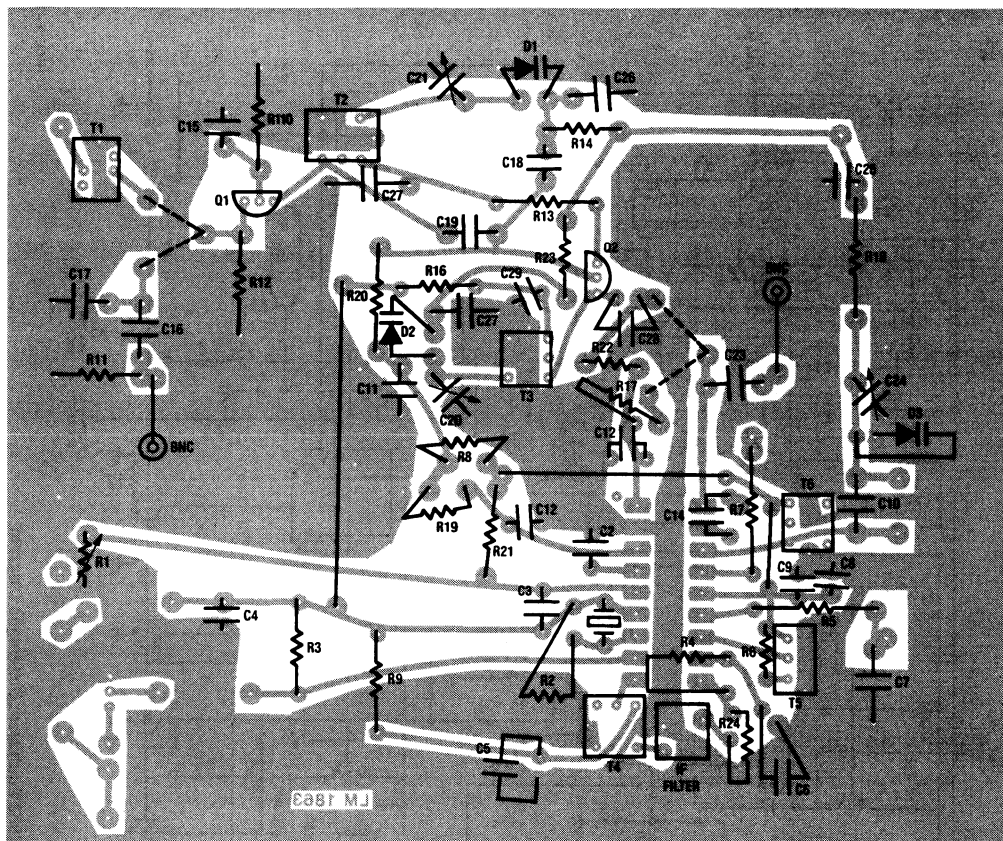


FIGURE 16. AM ETR Radio

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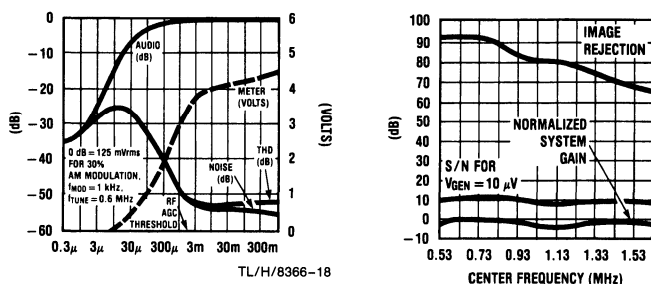
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FIGURE 17. LM1863 Circuit Board Layout

ed until it is within this range. Inject a low level modulated RF carrier at 600 kHz through the dummy antenna circuit and adjust the tuning voltage until the L.O. frequency is 1050 kHz. Peak T_2 and T_3 for maximum recovered audio, decreasing the RF carrier level if necessary to keep the signal below the AGC threshold (less than 100 μ Vrms input levels). Change the RF carrier frequency to 1500 kHz with a corresponding change in the L.O. tuning voltage for an L.O. frequency of 1950 kHz. Trim the RF capacitors C_{20} and C_{21} for maximum recovered audio. This process should be repeated until both carrier frequencies produce maximum

recovered audio. As a further check, measure the gain at 530 kHz and 750 kHz carrier frequencies and adjust the RF coils so that the recovered audio is about the same at either frequency. If this procedure is followed, the total gain variation should be less than 6 dB across the entire AM band.

Typical performance curves for the completed radio are shown in Figure 18 and an equivalent schematic for the I/C appears in Figure 19. In conclusion the LM1863 offers a high quality AM radio signal processing circuit, and is particularly well suited to radios using varactor tuning and frequency synthesis.



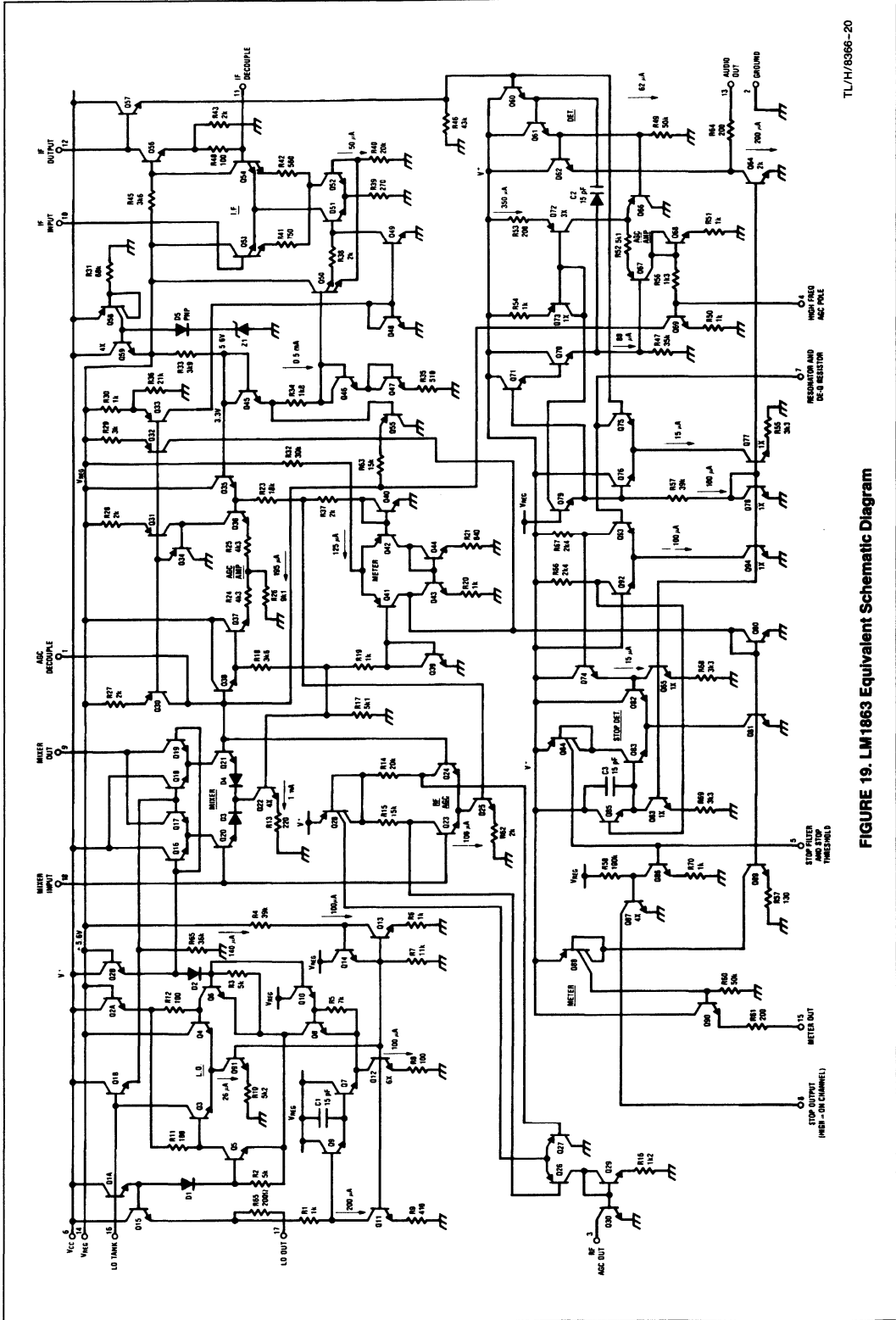
TL/H/8366-18

TL/H/8366-19

FIGURE 18. AM Radio Performance Curves

Additional Performance Information:

- *THD for 80% modulation for $f_{MOD} = 1$ kHz at:
 $V_{GEN} = 1$ V is 0.5%
 $V_{GEN} = 10$ mV is 0.4%
- *Tweed <2% at all input levels.
- *Typical time for valid stop indication < 50 ms.



TLH/8386-20

FIGURE 19. LM1863 Equivalent Schematic Diagram

AM and FM Integrated Circuits For Electronically Tuned Radios

National Semiconductor
 Application Note 382
 Martin Giles and Donald T. Wile



INTRODUCTION

The increasing availability of digital tuning systems using phase locked loops to control the radio local oscillator (L.O.) frequency and R.F. tuning, and the anticipated introduction of an AM stereo broadcast service, has motivated the development of a new set of integrated circuits (I/Cs) specifically designed to handle the broadcast signal processing functions of the radio. Features such as a valid station stop detector are provided for interfacing with the tuning system, and improved FM performance is achieved together with the use of dual-threshold AGC circuits and a novel low distortion quadrature detector. Special attention has been paid to the AM circuit design in order to accommodate the proposed AM stereo broadcast formats.

Digitally or electronically tuned radio receivers have been in existence for a number of years. Recent I/C developments, including the use of low cost general purpose controller I/Cs, have made digital tuning feasible for applications over a broad product line. Probably nowhere is this more important than in the automobile radio, where easy pushbutton tuning isn't merely a convenience but a significant safety factor. Electronic tuning is also able to offer a number of features such as:

- 1) Accurate tuning of the desired station, without drift.
- 2) A display of the actual station frequency.
- 3) Memory recall of preferred stations.
- 4) Scanning capability through the band.

- 5) Remote or "detachable" location of the control panel.
- 6) The potential for completely "knob-less" controls.

To properly achieve the station scanning function (4), it is necessary for the signal processing circuits of the radio to provide an indication that a station is actually present on the frequency to which the radio is tuned. This feature is particularly convenient when the car driver is unfamiliar with the local station allocations.

Before going into the details of the signal processing I/Cs, it is appropriate to briefly review the digital tuning process shown in the block diagram of *Figure 1*. Essentially the control mechanism consists of a reference oscillator with a fixed (or hard wired) divider, a programmable divider and a phase detector. The radio local oscillator provides one input to the phase detector through the programmable divider where it is compared with the divided down reference frequency. Any difference between these inputs will generate a control voltage that is filtered and used to correct the L.O. frequency. Clearly, to allow incrementing the L.O. frequency through the relevant band, the phase detector input frequencies must be equal to, or some submultiple of, the R.F. carrier spacing. Where possible it is desirable to keep this detector input frequency high, to simplify filtering the control voltage yet retaining sufficient loop bandwidth to accommodate rapid station changes. Table 1 summarizes the typical options that are available in the PLL synthesizer I/Cs, DS8906/07/08.

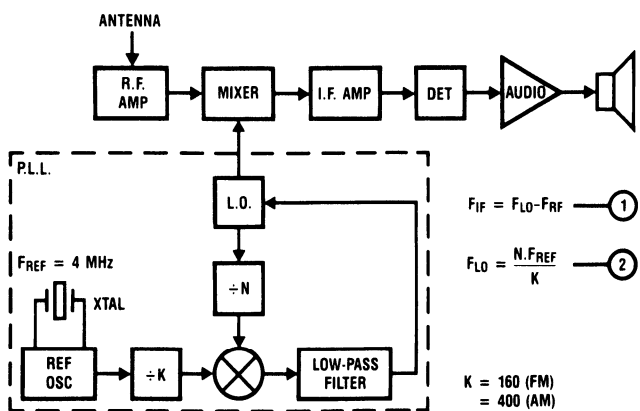


FIGURE 1. Electronically Tuned Radio Functional Blocks

TL/H/8367-1

TABLE I. PLL Synthesizer Options

F_{REF}	Phase Detector Input Frequency, F $\left(F = \frac{F_{LO}}{N} = \frac{F_{REF}}{K} \right)$	
	FM	AM/SW
4 MHz	12.5 kHz	500 Hz
4 MHz	25 kHz	10 kHz
3.96 MHz	1 kHz	1 kHz
	9 kHz	9 kHz
	10 kHz	10 kHz
	20 kHz	20 kHz

Figure 2 shows a further development of the synthesized tuning radio. A control I/C is used to set the dividers in the PLL synthesizer I/C, and to send serial data to drive a display which indicates the selected station frequency. A keyboard (or pushbuttons) enables the user to choose the station from memory or to scan the band. Another connection is made from the signal processing circuits to provide the stop indication that confirms a station is operating on the RF carrier frequency that is being scanned. The controller, a COP420L-HSB, determines the time allowed for this stop indication and, if one is received, either halts the scanning process or continues to the next valid station frequency after several seconds have elapsed. The time for the stop indication must be long enough that the station presence can be reliably indicated, yet short enough that scanning a sequence of vacant channels is not irritatingly long. Typically 50 msec is allowed for station identification and an 8 second pause occurs on valid stations before scanning is continued until the listener stops the process on the station of choice.

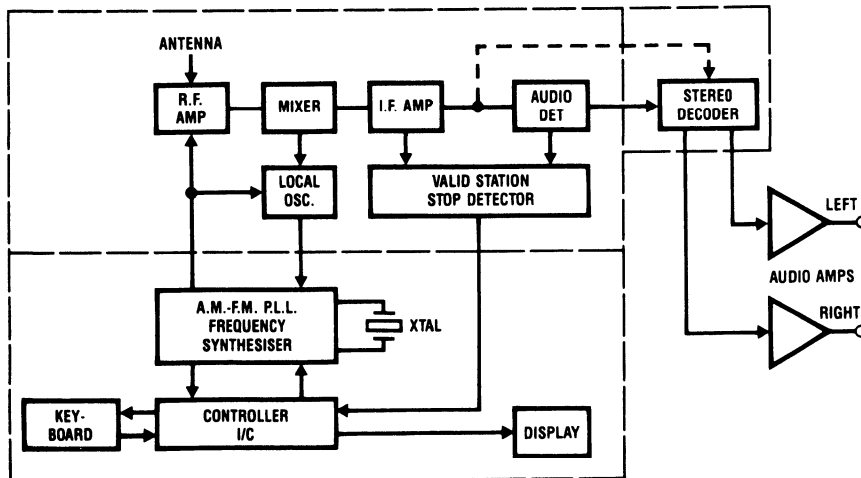


FIGURE 2. FM and AM Stereo Synthesized Tuning Frequency Radio

TL/H/8367-2

THE FM SECTION

The basic FM radio signal processing section is shown in Figure 3. The tuner gain is usually between 30 dB and 45 dB, with a 5 to 6 dB Noise Figure. While the tuned RF stage provides image frequency rejection and some attenuation of potentially interfering adjacent channel signals, the main selectivity is provided by the filter block between the tuner and the IF limiting amplifier. Ceramic filters have become popular since they are physically small and offer freedom from production alignment. FM ceramic filters are classified according to the center frequency and the micro-controller can be hardwired to provide the appropriate offset frequency for the PLL to match the tuner IF output to the filters that are being used. To meet the more stringent selectivity needs of automobile radio reception, two ceramic filters are required and additional gain is supplied in the IF amplifier in order to compensate for the insertion loss incurred with two filters. By building the gain block into the LM1865 we can simultaneously achieve proper matching of both filter impedances to assure minimum passband ripple and insertion loss.

An on-chip buffer amplifier means that the LM1865 will have a higher overall gain at the intermediate frequency. Special attention is paid to internal circuit stability as well as using a pin-out that enables stable connection of external components. For example, with an active gain of over 80 dB at 10.7 MHz and an input impedance of 300Ωs, the feedback capacitance from the output of the IF amplifier to the input must be less than 0.0045 pF! To ensure that this is the case, the buffer amplifier and the quadrature detector coil are at opposite ends of the I/C and the buffer amplifier has an additional power supply decoupling pin and a separate ground pin.

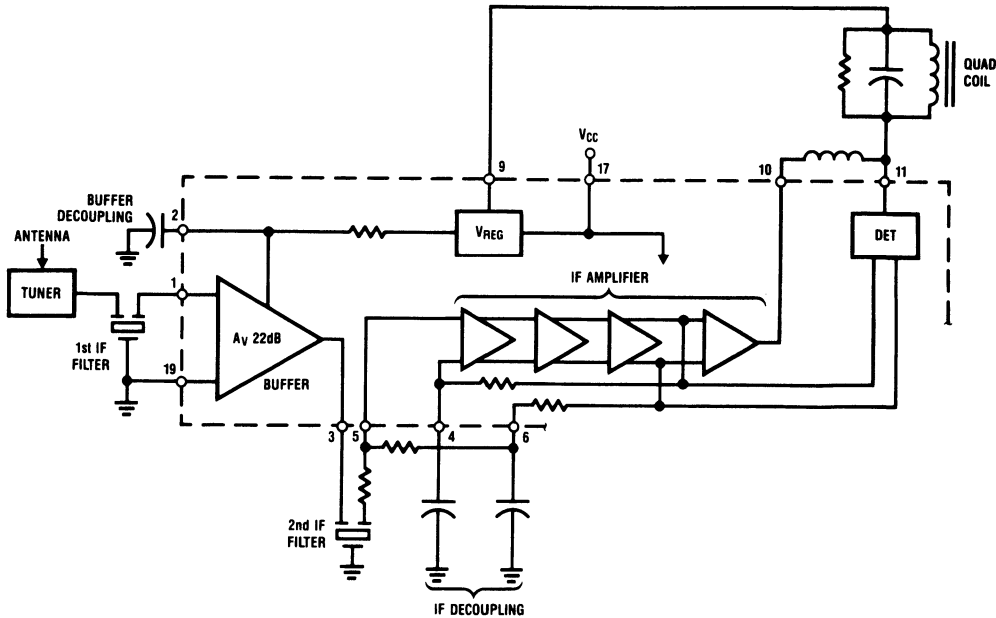


FIGURE 3. FM Signal Processing Stages

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Following the IF amplifier is the FM detector which, for low external component cost and ease of alignment, uses a single tuned quadrature coil. This part of the design can usually be a significant contributor to distortion in the recovered audio when large signal frequency deviations cause detector operation in the non-linear portion of the quadrature coil phase characteristic. Solutions such as using double tuned quad coils will significantly complicate the radio alignment. To keep the simplicity of a single tuned coil, a new technique has been adopted which compensates for the coil phase non-linearity. As *Figure 4* shows, the recovered audio is full-wave rectified and the output of the rectifier used to modulate the detector multiplier current. The increase in the multiplier current as the audio signal reaches peak swings effectively straightens the detector S curve, giving very low distortion at high modulation depths.

Figure 4 also shows that a small part of the rectified audio current is added to a current source connected to one side of the multiplier output stage. Since the detector depends on a 90 degree phase difference between the signal input and the switching inputs to the multiplier, any internal I/C phase shifts at the intermediate frequency will mean that the quad coil must be slightly detuned from the center frequency in order to produce a compensating phase shift. This puts a dc component in the detected output which will offset the AFT circuit. The current source produces a corresponding offset at the multiplier output which enables the quad coil to be precisely tuned to the IF frequency for low distortion with no AFT offset. RF fine tuning will similarly create dc offsets at the detector output, and the feedback current produced by the audio rectifier added to these current sources will tend to counteract the tuning offset. The result is a detector circuit using a single coil that has low distortion over a wide RF tuning range. Since the AFT offset is minimized at the proper quad coil tuning point, production alignment resolves simply to tuning the coil for zero AFT output current.

Any AFT offset current is converted to a voltage by an external resistor connected back to the bias voltage supply for the detector multiplier. Two voltage comparators are also connected to the AFT output and a permissible offset voltage "window" is established by these comparators. For a manually tuned radio, the offset must come within this window for the audio stage to be un-muted, or in the case of an electronically tuned radio, for the I/C to give a stop scanning indication. Unfortunately the AFT output will not necessarily be offset when the ETR momentarily halts on a vacant channel and other means must be used to indicate the presence or absence of a valid station.

One method is to detect the signal level in the FM limiting amplifier, and the LM1865 includes signal detector circuits for each limiter stage in order to provide a signal strength meter drive or an input to the stop detector circuit.[†] This method is ideal when stopping is required only on relatively strong stations since the meter circuit accuracy for weaker signals is not precise and will require a threshold trim adjustment.

An alternative technique that allows stopping on signals with a S/N ratio between 45 dB and 60 dB, is to detect the ultrasonic noise content in the recovered audio output. With no signal present (or a very weak station) the audio output before the stereo decoder and FM de-emphasis will contain a significant amount of high-frequency noise. This is coupled via a high pass filter to a comparator that disables the stop detector output when the noise level is sufficiently high.

[†](The meter drive circuit is also commonly used to control the blend input for the FM stereo demodulator I/C (see LM1870 or LM4500 data sheets). This input is used for signal conditions for which the noise contribution of the stereo difference signal (L-R) is dominating the overall S/N ratio. The signal strength in the FM-IF is used to gradually blend the decoder output into the monaural mode, maintaining the S/N ratio at the expense of stereo separation.)

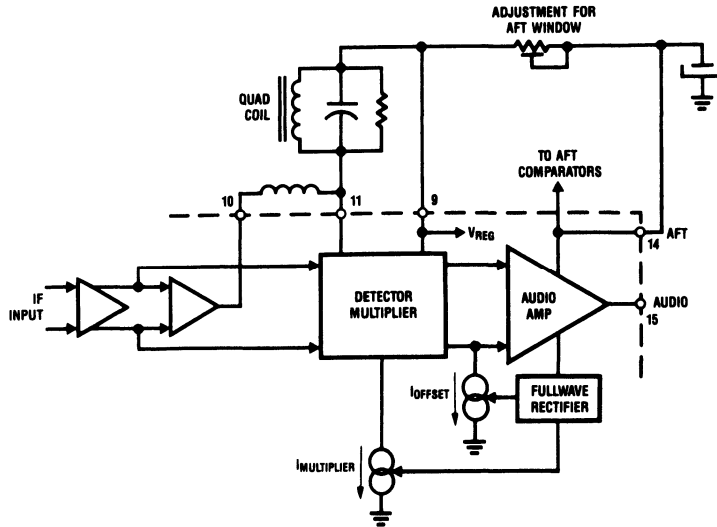


FIGURE 4. Detector Distortion Correction Circuit

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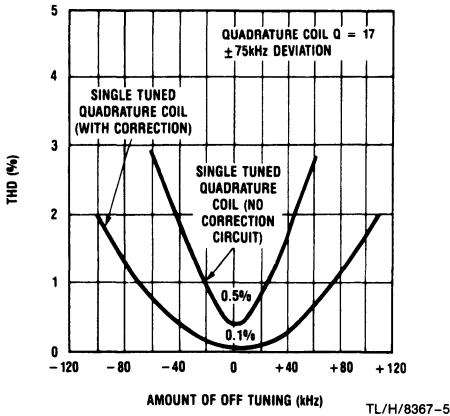


FIGURE 5. Detector Distortion vs Tuning

The highpass filter corner frequency will determine the noise level above which the stop detector is disabled and this is externally adjustable. As the audio S/N ratio improves, the noise level will fall until it is unable to trigger the comparator and the stop indicator is enabled. As the desired detection threshold S/N ratio is increased, less noise is generated at the input to the comparator and the pole of the highpass filter must be moved lower by changing the resistor connected to Pin 13 (Figure 6). However, a point will be reached where strong signals containing an SCA carrier or high stereo audio modulation frequencies will also be able to trigger the comparator preventing a stop indication. In this instance, if relatively high threshold S/N ratios are required, the AGC bus should be pulled during the scan mode to reduce the input signal level by about -10 dB, which will allow continued use of a filter pole equivalent to a lower threshold S/N ratio.

On the subject of AGC, it has been recognized for a number of years that gain reduction of the tuner, particularly in a mobile FM receiver, is important in preventing signal induced overloads. Previously radios have included a "local/

distant" switch on the front panel to address this problem. The LM1865 includes an improved AGC detector circuit that eliminates the need for this switch. Conventional AGC systems detect the signal either before the IF filters or after the filters. In each case there are disadvantages. If the AGC system looks at the signal before the IF filters reduce the system bandwidth, strong interfering signals within the wider RF bandwidth will cause tuner gain reduction, effectively desensitizing the radio to a weaker desired signal. AGC detection after the IF filters will avoid this but now the AGC threshold level is the result of a compromise; too high a setting will allow strong signals producing intermodulation to mask the desired signal, and too low a setting will cause premature AGC action even when no interfering signal is present, thus resulting in poorer S/N ratios.

To avoid the need for a local/distance switch to select the desired AGC operation depending on the signal conditions, a dual threshold AGC system is used with detection both before (wideband) and after (narrowband) the IF filters. The first, or wideband detector, is set to have a high threshold whereas the second, or narrowband detector, has a much lower threshold referred to the RF signal strength. Both detectors must reach their respective thresholds before AGC action can take place.

Two sets of signal conditions can be used to describe the operation of this AGC system. The first is simply a desired signal that is increasing steadily in level as the radio comes close to the transmitter. The narrowband detector reaches its threshold but no AGC action occurs until the higher wideband threshold is reached, thus optimizing the S/N ratio before the tuner is gain reduced. An interfering signal that is within the RF bandwidth but outside the IF bandwidth cannot cause AGC action because the IF filter will prevent it reaching the narrowband detector. The second set of signal conditions concerns a steadily increasing desired signal when a high level interfering signal strong enough to activate the wideband detector is simultaneously present. Despite the high level of the interfering signal, the tuner is not gain reduced because the interfering component cannot reach the narrowband detector. Thus, while the desired signal is still weak, the radio sensitivity has not been degraded

by premature AGC action. However, when the desired signal reaches the narrowband threshold, since the wideband threshold has already been activated by the interfering signal, early AGC action commences which will reduce the interfering level in the tuner. Depending on the relative level of the interfering signal, early or late AGC action can take place, removing the need for a manually activated local/distance switch.

A complete block diagram of the LM1865 is given in *Figure 8* and shows all the previously described sections with the appropriate pin outs. Because of the very high gain available from this I/C at 10.7 MHz, a few precautions are necessary in the p.c.b. layout. Referring to *Figure 9*, notice that the quadrature coil T_1 and the detector inductor L_1 are located at the opposite end of the board to the input stage, and that the first ceramic filter CF1 has the same ground point as the internal buffer amplifier (Pin 19). Similarly the second filter CF2 shares the same ground point as the IF decoupling capacitor C4.

TABLE II. Performance Summary

Static Characteristics	
Supply Current	33 mA
Operating Voltage Range	7.3V Min 16.0V Max
Dynamic Characteristics $f_{MOD} = 400$ Hz, $f_o = 10.7$ MHz, Deviation = ± 75 kHz	
-3 dB Limiting Sensitivity*	60 μ Vrms
Buffer Voltage Gain	22 dB
Recovered Audio	390 mVrms
Signal-to-Noise	84 dB
AM Rejection	60 dB
Minimum Total Harmonic Distortion	0.1%
THD at Frequency Where $V_{14} = V_9$ (Zero AFT Offset)	0.1%
THD ± 10 kHz from Frequency Where $V_{14} = V_9$	0.15%
Narrowband AGC Threshold	200 μ Vrms
Wideband AGC Threshold	9 mVrms

*Does not include Buffer Amplifier gain of 22 dB.

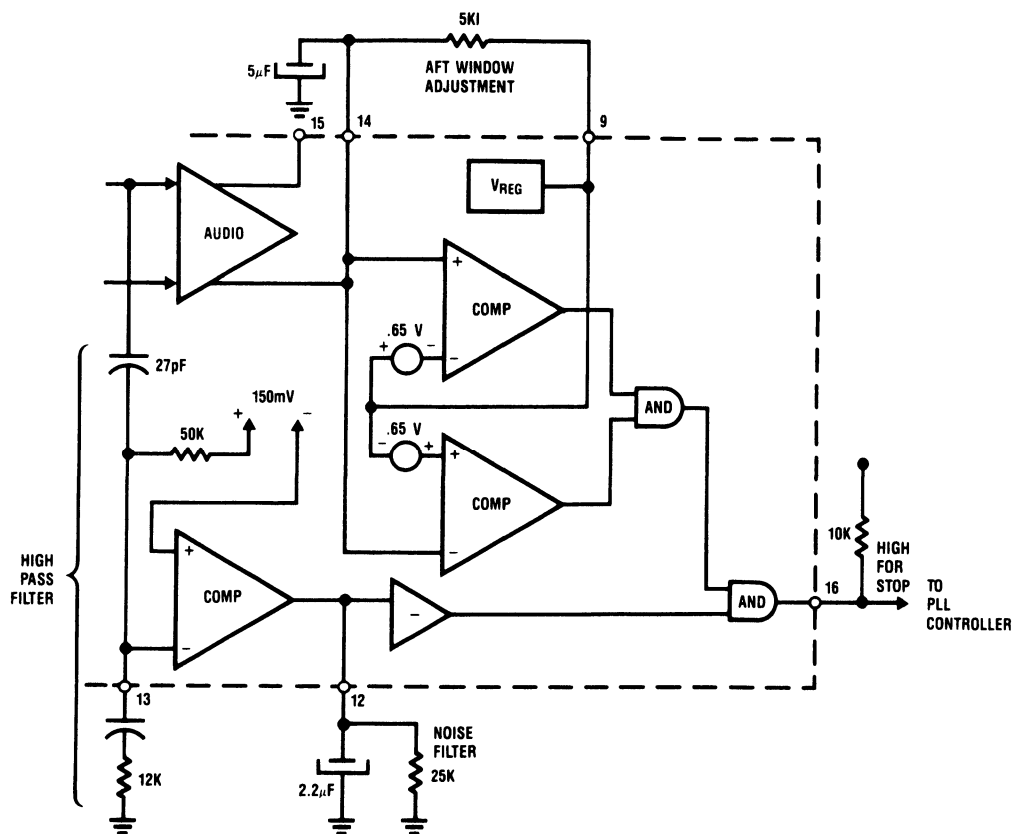
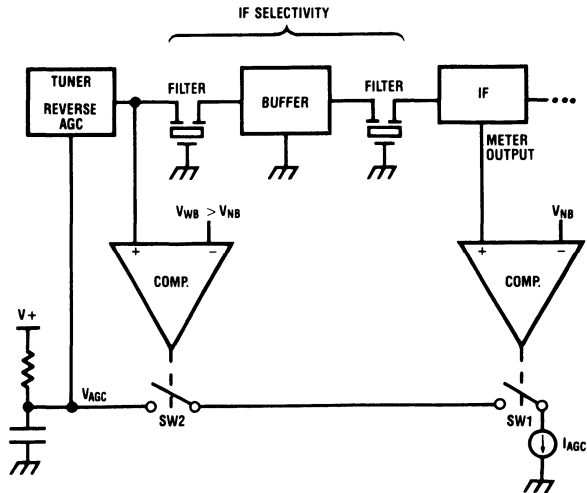


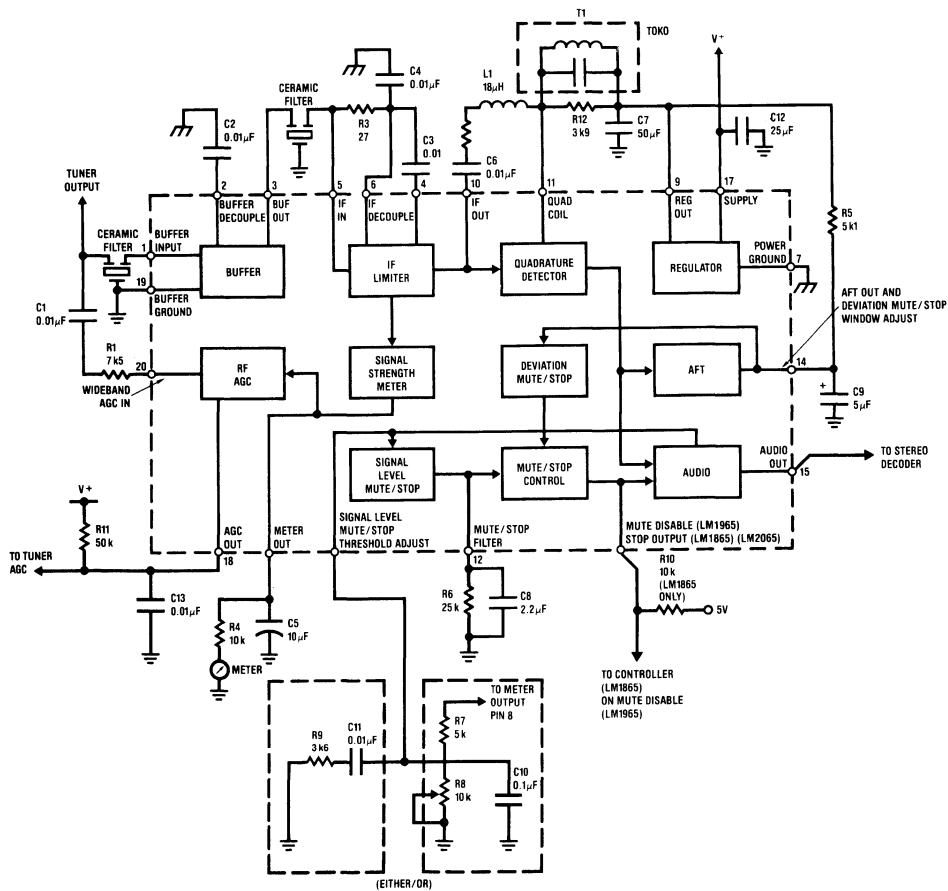
FIGURE 6. Valid Station Detection Circuit

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TL/H/8367-7

FIGURE 7. Dual-Threshold AGC System



TL/H/8367-8

FIGURE 8. Application Circuit

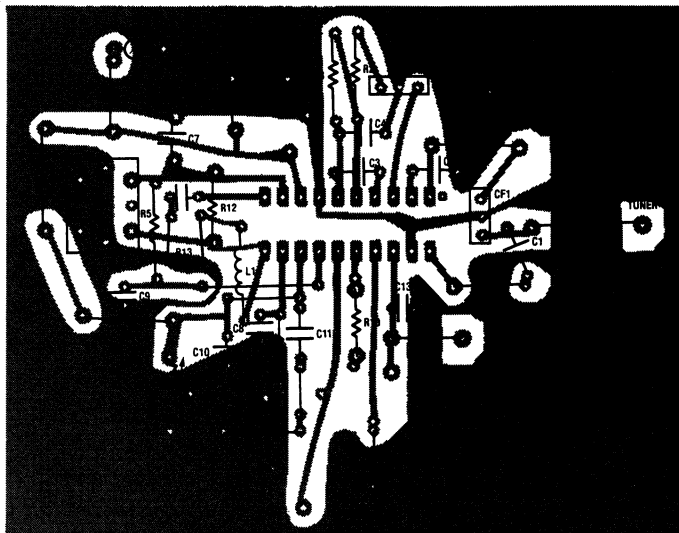


FIGURE 9. PC Layout (Component Side)

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THE AM SECTION

Considerable interest in being paid to the AM section of the automotive radio, not only for the electronic tuning function, but also for the new circuits required to process the proposed AM stereo formats. It might appear that the only change from a conventional radio is the addition of the appropriate stereo decoder and the replacement of tuning capacitors with voltage controlled varactor diodes. This is not the case. The conversion to electronic tuning and the addition of a stereo signal means that each part of the AM receiver requires careful re-design if an acceptable performance level is to be achieved. This next section describes the LM1863 that has been designed with the needs of the AM stereo electronically tuned radio in mind.

Re-design begins right at the antenna. Because the signal strength at the input to an automobile radio receiver can vary widely (or wildly), the antenna matching circuit is often the result of a compromise between risking poor crossmodulation performance or padding the signal level down so that the SNR and radio sensitivity suffer from the consequent insertion loss. For manually tuned radios, a single-tuned circuit has proven popular, but the large input capacitance of the automotive whip antenna and coupling cable makes this approach impractical for an electronically tuned radio using varactor diodes. The solution shown here (*Figure 10*) is to use an untuned antenna input with a discrete F.E.T. device able to handle large signal swings with good crossmodulation performance. A transistor stage (Q_2) couples the signal from the F.E.T. to the mixer input of the LM1863 with tuned circuits at both the input and the output of the transistor stage to provide the necessary RF selectivity for good image rejection.

This RF input stage employs a unique scheme for ensuring uniform sensitivity of the radio across the AM band. For conventional tuned circuits, the center frequency changes over a 3:1 ratio with a corresponding 3:1 change in the parallel resonant impedance. This means that the radio is generally more sensitive at the high frequency end of the band.

In the circuit of *Figure 10*, the main signal path is through C_{19} into the base of Q_2 , and tuning is provided by D_1 , C_{21} , C_{26} and T_1 secondary coil. However, at AM radio frequencies C_{26} is not a complete bypass to ground, and the signal appearing at the junction of C_{26} and the cathode of the varactor diode D_1 is also coupled to the base of Q_2 through C_{18} . At the low end of the AM band where the gain of Q_1 and Q_2 is reduced by the decrease in the reflected impedance from T_1 and T_2 secondary circuits, D_1 capacitance is high and more signal is coupled through C_{18} , thus compensating for the drop in gain. At high RF frequencies, D_1 capacitance is lower and less compensating signal passes through C_{18} . By this means the overall RF gain change across the AM band is reduced from over 14 dB to less than 6 dB (including tracking errors).

The signal passes from the RF stage into a doubly balanced mixer stage which offers good intrinsic IF rejection. From the mixer output, the signal is coupled to the IF amplifier via a ceramic filter which is the main selectivity element. The mixer input amplitude is also detected and used to provide an RF AGC voltage above a certain input level. This is particularly important to prevent strong RF signals overloading the mixer and causing intermodulation, crossmodulation and tweet. The RF AGC voltage pulls down the base of Q_2 and reduces the gain of Q_1 by forcing Q_1 to operate in its low gain resistive region. In this way, large RF signal swings are prevented from appearing across either of the RF tuning varactors and causing poor crossmodulation performance or poor tracking. The RF AGC threshold has been carefully chosen to prevent mixer overload but also to be as high as possible to minimize the chance of strong adjacent channel signals activating the RF AGC and effectively desensitizing the radio. At signal levels below the RF AGC threshold, the detector output is held relatively constant by a combination of IF amplifier and mixer stage AGC. This ensures that the RF gain is held high for good S/N ratios and low T.H.D. The valid station stop detection time is dominated by the AGC

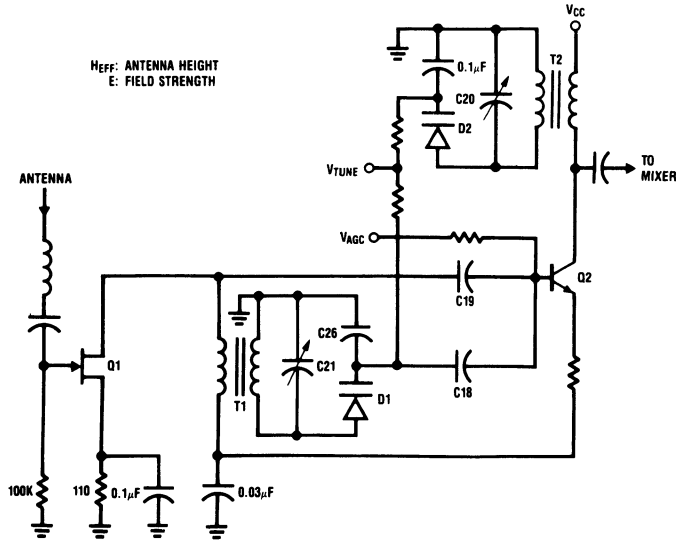


FIGURE 10. Improved RF Input Stage

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settling time and the AGC loop filter response has two poles provided by external capacitors. If a single pole filter was used, fast settling times would cause high audio distortion as the AGC system attempted to track the modulation envelope. By using a two-pole filter, valid station stop detection times of under 50 ms have been achieved with a factor of ten improvement in audio T.H.D. compared to conventional AGC system performance.

The local oscillator circuit has been designed for very low phase noise in anticipation of AM stereo signals using angle modulation of the RF carrier. For a conventional AM envelope detector circuit, phase variations in the carrier frequency are ignored, but these same phase variations in the PM channel will be interpreted as noise, distortion and loss of stereo separation. The potential severity of this problem can be appreciated when it is realized that the typical peak deviation (for 100% [L-R] modulation) of the RF carrier for the proposed systems is of the order of only 1 radian! The L/C oscillator circuit of the LM1863 has a phase signal to noise ratio better than 60 dB. This will be degraded 3 to 4 dB by thermal noise generated in the resistors supplying the varactor tuning control voltage, and the PLL control voltage itself is a potential source of phase noise. In all cases the phase noise is predominantly low frequency, suggesting that a weighted noise measurement (such as CCIR/ARM) may be more appropriate.

The amplitude of the oscillator signal is controlled over the AM band to compensate for the changes in the tuned circuit dynamic resistance (R_p) with changes in operating frequency. Both the RF and the LO varactors are controlled by the same voltage developed at the phase detector output of the PLL. LO amplitude variations with tuning frequency can modulate the LO varactor capacitance, necessitating a change in the control voltage. This retunes the RF stages resulting in a tracking error. When the LO amplitude is controlled, tracking errors are minimized. A buffered LO output is provided for the programmable divider in the PLL circuit.

As mentioned earlier, the radio selectivity characteristic is determined predominantly by the ceramic filter connected between the mixer output and the IF amplifier input. With a

relatively wide bandwidth RF stage, this filter will have a major impact on the quality of the recovered audio, particularly for a stereo signal. New filters are being developed with good group delay for lower distortion and with wider bandwidths to accommodate the stereo signal. Even so, it is unlikely that audio bandwidths greater than 7-8 kHz are going to be used if the radio immunity to adjacent channel interference is not to be degraded. This is especially true for nighttime reception when reduction of the bandwidth to less than 4 kHz may be necessary because of distant station propagation by the sky-wave.

For a stereo receiver, the signal is taken from the IF output to enable the PM signal to be detected. In this case the internal LM1863 envelope detector is used to develop the IF AGC voltage and the signal strength meter drive. This signal strength indication is used as one input to the valid station

TABLE III. Performance Summary

Static Characteristics

Supply Current	8.2 mA
Operating Voltage	7.0-16V

Dynamic Characteristics

MODN 30%	$f_{MOD} = 1 \text{ kHz}$, $f_o = 1.0 \text{ MHz } 30\% \text{ MOD}$
Maximum Sensitivity	2.2 μV
20 dB Quieting	30 μV^*
S/N (10 mV Input)	54 dB
THD	0.2%
Audio Output	125 mV
Stop Signal Threshold	50 μV^{**}
Stop "Window"	4 kHz
Stop Time	< 50 ms
RF Bandwidth	28 kHz
Image Rejection	> 70 dB
RF AGC Threshold	3 mV*

* With 16 dB Antenna Pad

**Externally Adjustable

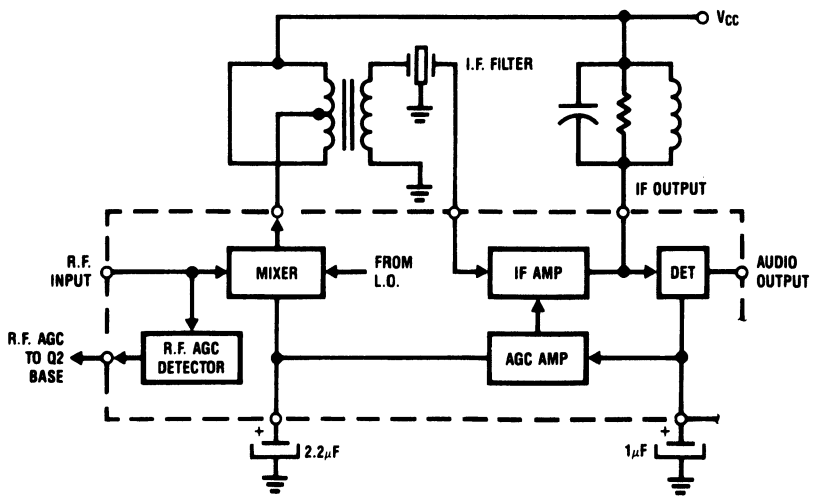


FIGURE 11. Mixer, IF Amplifier and AGC Detector Stages

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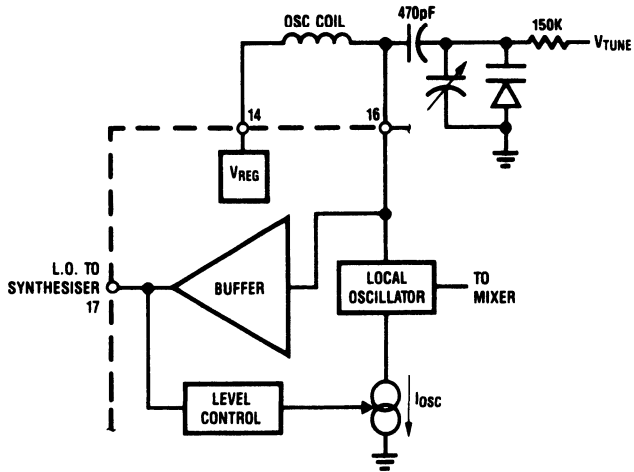


FIGURE 12. Controlled Amplitude Local Oscillator

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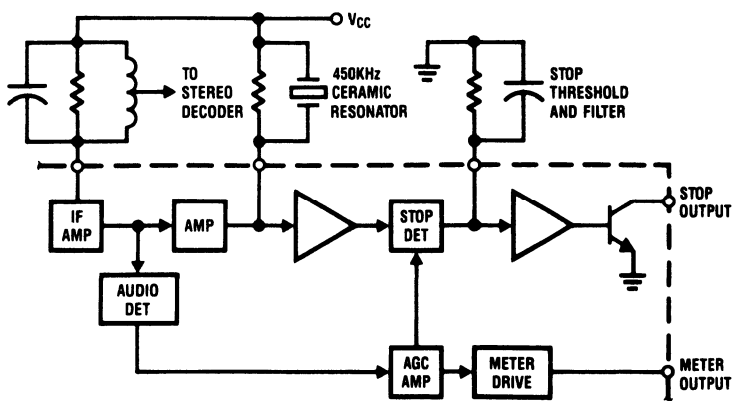


FIGURE 13. Automatic Station Stop Detector

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stop detector circuit for the electronically tuned radio. The other required input is from a limiter amplifier connected to the IF output. The limiter signal is applied to a low-cost ceramic resonator tuned to the IF frequency. Both the signal level threshold and the frequency "window" of the stop detector are externally adjustable.

Typical characteristics of the LM1863, including the RF stage, are shown in Table III. A complete block diagram of the LM1863 is shown in Figure 14 with a suitable p.c.b. layout in Figure 15. Alignment is more complicated than for the LM1865, so jumper leads are provided from the base of Q₂ and the mixer input of the LM1863 (Pin 18). Initially the IF amplifier is aligned by injecting a 10 μ Vrms, 1 MHz carrier at the mixer input and setting the tuning control voltage (normally derived from the PLL frequency synthesizer) so that the L.O. runs at 1.45 MHz. The mixer and IF coils (T₄ T₅) are peaked iteratively to produce the maximum recovered audio. The L.O. coil is then tuned to 980 kHz with a

fixed 1 VDC tuning control voltage. After tuning, if the control voltage is not between 7.5 VDC and 9.5 VDC when the L.O. frequency is 2060 kHz, the trimmer capacitor C₂₄ is adjusted and the coil re-tuned. Similarly the RF coils (T₂ T₃) are peaked for maximum recovered audio with a 600 kHz carrier, and the trim capacitors C₂₀ and C₂₁ adjusted for maximum recovered audio at 1500 kHz. Again, some iteration is likely before the RF gain is approximately matched across the AM band.

Conclusion

The increasing popularity of electronic tuning for radios, and the introduction of AM stereo services has meant that a number of changes in the conventional radio design are required. This paper has discussed some of these changes and shown how new integrated circuits can be used to obtain high quality performance in addition to the new features.

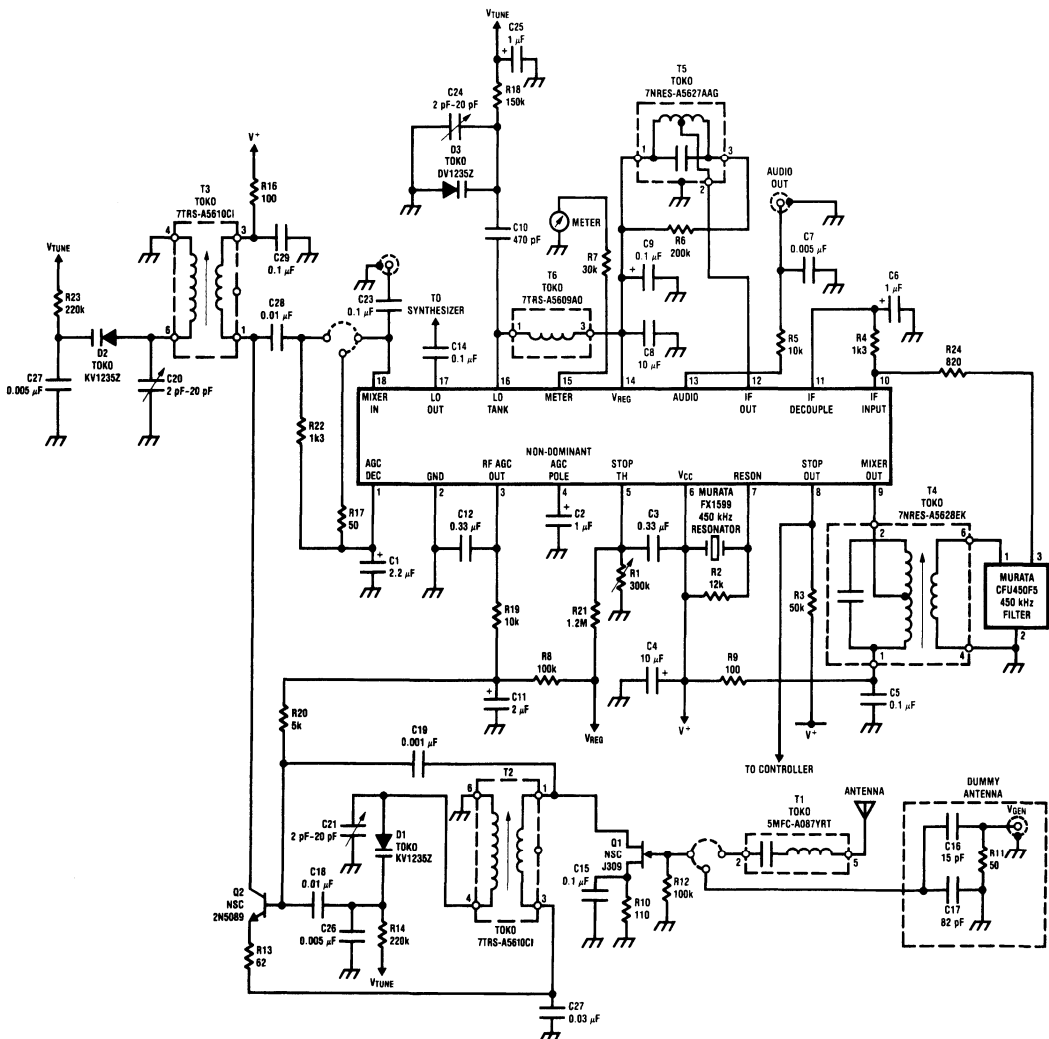


FIGURE 14. Application Circuit of the LM1863

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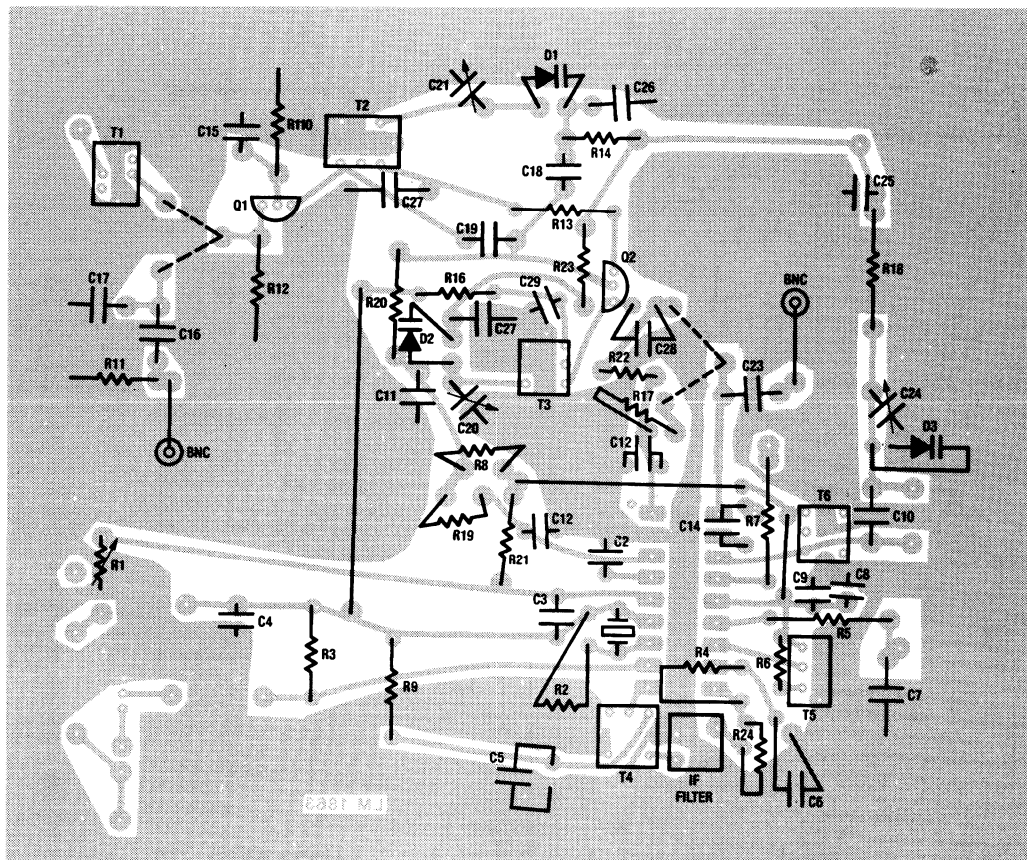


FIGURE 15. PC Layout (Component Side)

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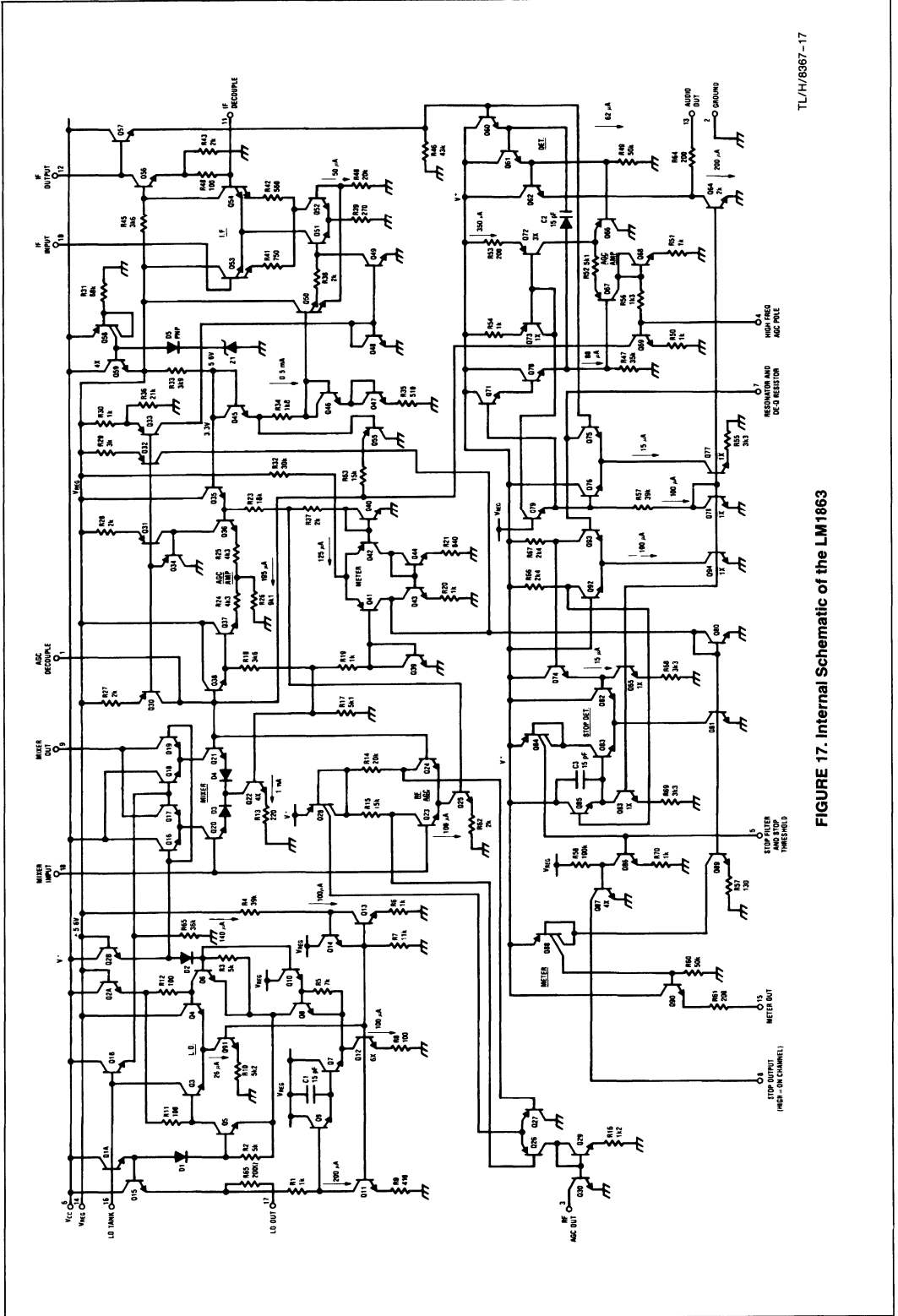


FIGURE 17. Internal Schematic of the LM1863

References

1. AN-335, Davis, Mills, Mueller: Digital PLL Synthesis, National Semiconductor, April, 1983.
2. DS8906, DS8907, DS8908 DATA SHEETS: National Semiconductor
3. COPs MM57110N DATA SHEET: National Semiconductor
4. LM1865 DATA SHEET: National Semiconductor
5. LM1863 DATA SHEET: National Semiconductor
6. LM1870, LM4500 DATA SHEET: National Semiconductor

Audio Noise Reduction and Masking

National Semiconductor
Application Note 384
Martin Giles



AN-384

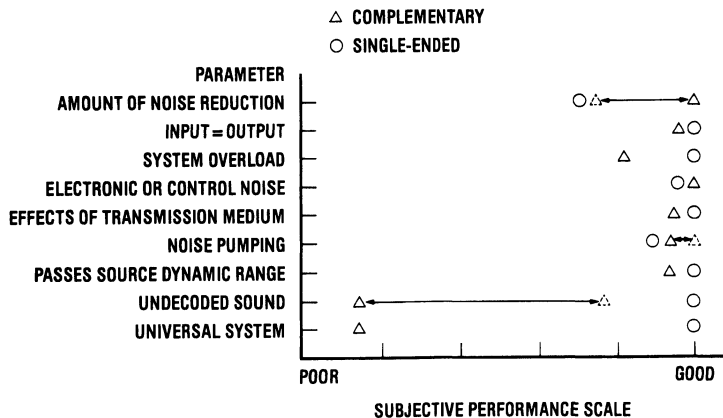
INTRODUCTION

Audio noise reduction systems can be divided into two basic approaches. The first is the complementary type which involves compressing the audio signal in some well-defined manner before it is recorded (primarily on tape). On playback, the subsequent complementary expansion of the audio signal which restores the original dynamic range, at the same time has the effect of pushing the reproduced tape noise (added during recording) farther below the peak signal level—and hopefully below the threshold of hearing.

The second approach is the single-ended or non-complementary type which utilizes techniques to reduce the noise level already present in the source material—in essence a playback only noise reduction system. This approach is used by the LM1894 integrated circuit, designed specifically for the reduction of audible noise in virtually any audio source.

While either type of system is capable of producing a significant reduction in audible noise levels, companders are inherently capable of the largest reduction and, as a result, have found the most favor in studio based equipment. This would appear to give companders a distinct edge when it comes to translating noise reduction systems from the studio or lab to the consumer marketplace. Companders are not, unfortunately, a complete solution to the audio noise problem. If we summarize the major desirable attributes of a noise reduction system we will come up with at least eight distinct things that the system must do—and no system as yet does all of them perfectly.

- 1) The reproduced signal (now free of noise) is audibly identical to the original signal in terms of frequency response, transient response and program dynamics. The stereo image is stable and does not wander.
- 2) Overload characteristics of the system are well above the normal peak signal level.
- 3) The system electronics do not produce additional noise (including perturbations produced by the control signal path).
- 4) Proper response of the system does not depend on phase/frequency or gain accuracy of the transmission medium.
- 5) System operation does not cause audible modulation of the noise level.
- 6) The system enables the full dynamic range of the source to be utilized without distortion.
- 7) The recorded signal sounds natural on playback—even when decoding is not used. This means that the system is compatible with existing equipment.
- 8) Finally, the system is universal and can be used with any medium; disc, FM broadcast, television broadcast, audio and video tapes.

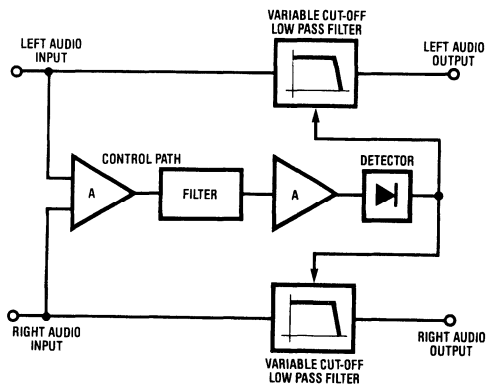


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FIGURE 1. Comparison of Noise Reduction Systems

Although no system presently meets all these requirements—and the performance level they do reach is often judged subjectively—they provide a useful set of performance standards by which to judge the n.r. systems that are available. In particular, in the consumer field items 7) and 8) are significant. The most popular n.r. system, Dolby B Type, got that way in part because pre-recorded and encoded tapes could be played back on tape-decks that did not have Dolby B decoders (Dolby B uses a relatively small amount of compression and that only for low level higher frequency signals). Similarly, DNRTM, which uses the LM1894, is gaining in popularity because it does not require any encoding and, in addition, can work with any audio source, including Dolby B encoded tapes.

DNR is a non-complementary noise reduction system which can give up to 14 dB noise reduction in stereo program material. The operation of the LM1894 is dependent on two principles; that the audible noise is proportional to the system bandwidth—decreasing the bandwidth decreases the noise—and that the desired signal is capable of “masking” the noise when the signal to noise ratio is sufficiently high. DNR automatically and continuously changes the system bandwidth in response to the amplitude and frequency content of the program. Restricting the bandwidth to less than 1 kHz reduces the audible noise by up to 14 dB (weighted) and a special spectral weighting filter in the control path ensures that the bandwidth is always increased sufficiently to pass any music that may be present. Because of this ability to analyze the auditory masking qualities of the program material, DNR does not require the source to be encoded in any special way for noise reduction to be obtained.



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FIGURE 2. Stereo Noise Reduction System (DNR)

NOISE REDUCTION BY BANDWIDTH RESTRICTION

The first principle upon which DNR is based—that a reduction in system bandwidth is accompanied by a reduction in noise level—is rather easy to show. If our system noise is assumed to be caused solely by resistive sources then the noise amplitude will be uniform over the frequency bandwidth. The total or aggregate noise level \bar{e}_{NT} is given by the familiar formula

$$\bar{e}_{NT} = \sqrt{4 KTB\bar{R}} \quad (1)$$

where K = Boltzmann's const^t

T = absolute temp.

B = bandwidth

R = source resistance

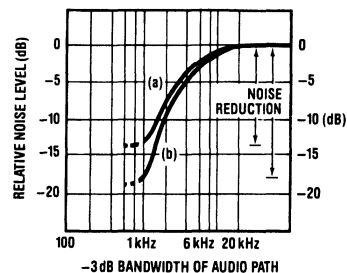
At any single frequency, the noise amplitude measured in a bandwidth of 1 Hz is e_n , and therefore

$$\bar{e}_{NT} = \bar{e}_n \sqrt{B} \quad (2)$$

This shows that the total noise, and hence the S/N ratio, is directly proportional to the square root of the system bandwidth. For example, if the system bandwidth is changed from 30 kHz to 1 kHz, the aggregate S/N ratio changes by

$$20 \log_{10} \sqrt{1 \times 10^3} - 20 \log_{10} \sqrt{30 \times 10^3} = -14.8 \text{ dB}$$

This result, although mathematically correct, is not exactly what will occur in practice for several reasons. Most audio systems will have a generally smooth noise spectrum similar to white noise, but the amplitude is not necessarily uniform with frequency. In audio cassette systems where the dominant noise source is the tape itself, the frequency response often falls off rapidly beyond 12 kHz anyway. For video tapes with very slow longitudinal audio tracks, the frequency response is well below 10 kHz, depending on the recording mode. Disc noise generally increases towards the low frequency end of the audio spectrum whereas FM broadcast noise decreases below 2 kHz. On the other hand, the frequency range of the noise spectrum is not always indicative of its obtrusiveness. The human ear is most sensitive to noise in the frequency range from 800 Hz to just above 8 kHz. Because of this, a weighting filter inserted into the measurement system which gives emphasis to this frequency range, produces better correlation between the S/N “number” and the subjective impression of noise audibility. Generally speaking, a typical tape noise spectrum and a weighting filter such as CCIR/ARM will yield noise reduction numbers between 10–14 dB when a single pole low pass filter is used to restrict the audio bandwidth to less than 1 kHz. Up to 18 dB noise reduction is possible with a two pole low pass filter. Consistent with the many reported experiments on ear sensitivity (Fletcher-Munson, Robinson-Dadson etc.) we see that decreasing the bandwidth below 800 Hz is not particularly beneficial, and that once the bandwidth is above 8 kHz, there is little perceived increase in the audible noise level.



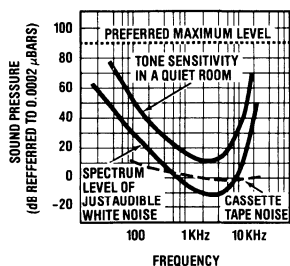
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FIGURE 3. Reduction in Noise Level with Decreasing Bandwidth Audio Cassette Tape Noise Source—CCIR/ARM Weighted a) single pole low pass filter; b) two pole low pass filter

AUDITORY MASKING

Obviously restricting the system bandwidth to less than 1 kHz in order to reduce the noise level will not be very satisfactory if the program material is similarly restricted, and this is where the second operating principle of DNR comes into play—whenever a sound is being heard it reduces the ability of the listener to hear another sound. This is known as auditory masking and is not a newly discovered phenomenon. It has been investigated for many years, primarily in connection with noise masking the ability of the listener to hear tones. The measurements have been made

under steady state conditions and are summarized in the curves of *Figure 4*. Before discussing the shape of the curves and the conclusions that can be drawn it is worth looking at the scales employed. One difficulty that occurs in evaluating electronic equipment for audio is to be able to relate a quantity measured in electrical terms to the subjective stimulus (hearing) that it produces. For audio we are most interested in the conversion of electrical power into acoustic power. Since neither sound power nor sound intensity can be measured directly, we must use a related quantity known as sound pressure level (SPL) as our reference scale in *Figure 4*. The reference sound pressure, which approximates the threshold of hearing at 1 kHz is 0.0002 μ Bars ($10^6 \mu$ Bars = 1 Bar = 1 atmosphere). For this sound pressure scale, the level at which noise spectra will appear depends on the degree of amplification we are giving the desired signal to produce the maximum anticipated sound pressure. Typically a maximum preferred listening level is +90 dB (SPL) and the assumption is made that the total audio system, including speakers, is producing this SPL at the listener's ear when the recorded level (on tape, for example) corresponds to OVU. By comparing the amplitude of noise spectra with this OVU level signal we obtain the tape noise curves of *Figure 4* and can compare them with the audible noise threshold. Increasing the volume level by 10 dB (say), to compensate for a lower recording level will raise all the *noise spectra curves* by 10 dB. The audible noise threshold curve *does not change* with changes in SPL produced by twiddling the volume control (except after prolonged listening at high levels) since it depends on the characteristics of the ear and partly upon the masking effects of room noise.



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FIGURE 4. Relating the Spectral Sensitivity of the Ear to Tones and Audible Noise with the Noise Output Level from an Electric Source

The upper solid curve in *Figure 3* shows the sensitivity of the ear to pure tones in a typical room environment. Notice that tones at very low frequencies and at very high frequencies must be much louder than tones at mid-frequencies in order to be heard. The lower solid curve shows the spectrum level of just audible white noise. This curve is some 20 dB–30 dB below the tone spectrum because, unlike a single tone, noise has spectral components at all frequencies. Noise spectra at frequencies either side of a specific frequency contribute to the auditory sensation and thus can be heard at a lower threshold level. The two curves also imply that noise at or above the lower curve is able to completely mask single tones on the upper curve. Also sources with noise spectra above the lower curve are going to be audible. Clearly for cassette tapes we need to push the noise level down by another 10 dB if it is to be inaudible at preferred listening levels. If the tape is under-recorded and the volume level increased to compensate, yet more noise reduction is needed.

Reversing these conclusions to determine the ability of tones to mask the noise is not as easy. The hearing mechanism in the ear involves the basilar membrane which is approximately 30 mm long by 0.5 mm wide. The nerve endings giving the sensation of hearing are spaced along this membrane so that the ability to hear at one frequency is not masked at another frequency when the frequencies are well separated. White noise can excite the entire basilar membrane since it has spectral components at all frequencies. For any single frequency therefore, there will be a band of noise spectra capable of simultaneously exciting the nerve endings that are responding to the single frequency—and masking occurs. Conversely, a single tone at the upper curve level is quite incapable of masking noise spectra at the lower curve level since it can only excite nerve endings at one particular point on the membrane. Noise spectra at frequencies on either side of the tone will still excite different parts of the membrane—and will be heard. Extremely high SPL's are required if single tones are to raise the audible noise threshold level and provide masking. As might be expected, the most effective tone frequencies are near the natural resonance of the ear—between 700 Hz and 1 kHz—and even then SPL's higher than 75 dB are needed for masking noise at 16 dB SPL. Fortunately for n.r. systems in general, including companders, this applies only to pure tones. As soon as the tone acquires distortion, frequency modulation or transient qualities, or a mixture of tones is present, the masking abilities change dramatically. Typically music and speech, with high energy concentration around 1 kHz, can be regarded as excellent noise masking sources—up to 30 dB more effective than single tones. Therefore, recorded signals at an average level of 40–45 dB SPL will allow a full audio bandwidth to be used without the noise becoming audible. Signal levels lower than this can provide adequate masking, particularly if the source has employed dynamic range compression (FM broadcast for example), but speech and solo musical instruments are likely to betray noise modulation. These conclusions can apply equally to complementary noise reduction systems with the noise modulation effects depending on the degree of compression/expansion and the threshold level at which compression begins in the record chain.

CONTROL PATH FILTERING AND TRANSIENT CHARACTERISTICS

If the signal source always maintained a relatively high SPL, then there wouldn't be any need for an n.r. system. However, when the program material SPL momentarily drops, the noise is unmasked and becomes audible. Much of the design effort involved in n.r. systems is in making the system track the program dynamics so that unmasking does not occur—at least not audibly. Similarly when the program material increases abruptly following a quiet passage, the n.r. system must respond quickly enough that the audio material is not distorted. For DNR, this means that the -3 dB corner frequency of the low pass filters inserted in each audio channel must increase quickly enough to pass all the music yet decrease back to around 1 kHz in the absence of music to reduce the noise. Matching low pass filters are used with a flat response below the cut-off frequency, and a smoothly decreasing response (-6 dB/octave) above the cut-off frequency, which can be varied from 800 Hz to over 30 kHz by the control signal.

A first approach to generating this control signal might be to use a filter and a gain block, driving a peak detector circuit. Since the amplitude spectra of musical instruments falls off with increasing frequency, and the characteristics of the ear

are such that masking is most effective with sounds around 1 kHz, a reasonable filter for the control path might be low pass. This turns out *not* to be the case. To take a worse case situation (from the viewpoint of masking), when a French Horn is the dominant source, most of the energy is at frequencies below 1 kHz. If we were detecting this energy through a low pass filter, the control path would respond to the high amplitude and cause the audio filters to open to full bandwidth. Noise in the 2 kHz and above region would be promptly unmasked and audible. To avoid this, DNR uses a *highpass* filter in the control path. Below 1.6 kHz, the response falls at an 18 dB/octave rate. Above 1.6 kHz the filter response increases at a 12 dB/octave rate until a -3 dB corner frequency around 6 kHz is reached. After this the response is allowed to drop again and may include notches at 15.734 kHz (for television sound), or at 19 kHz to suppress the subcarrier pilot signal in FM stereo broadcasts. Returning to the case of the French Horn, the absence of high amplitude higher frequency harmonics means that the control signal will generate only a small increase in the audio bandwidth (depending on the sound level) and the noise will remain filtered out.

Contrasted with this, multiple instruments, or solo instruments such as the violin or trumpet, can have significant energy levels above 1 kHz which not only provide masking at higher frequencies but also require wider audio bandwidths for fidelity transmission in the audio path. Put another way, when the presence of high frequencies is detected in the control path we know that the audio bandwidth must be increased and that simultaneously large levels of signal energy are present in the critical masking frequency range. Since the harmonic amplitude can decrease rapidly with increase in frequency, the control sensitivity is raised at a 12 dB/octave rate up to 6 kHz to ensure that an adequate audio bandwidth is always maintained.

The attack and release times of the control path signal are also based on typical program dynamics and the characteristics of the human ear. If the detector cannot respond to the leading edge transient in the music, then distortion in the audio path will result from the initial loss of high frequency components. As might be expected, the rise time of any musical selection will depend on the instruments that are being played. An English Horn is capable of reaching 60% of its peak amplitude in 5 ms. For other instruments, rise-times can vary from 50 ms to 200 ms whereas a hand-clap can be as fast as 0.5 ms. With this data in mind, DNR has been designed with an attack time of 0.5 ms. A distinction should be made in the effects of longer attack times for DNR compared to a companding noise reducer. If the compander does not respond immediately to an input transient, then instantaneous overload of the audio path can occur, with an overshoot amplitude as much as the maximum compression capability. If the system does not have adequate headroom, this overshoot can cause audible effects that last for longer than the period of the overshoot. The DNR filters simply cannot produce such an overshoot by failure to respond to the input rise-time. Since the ear has difficulty registering sounds of less than 5 ms duration, and can tolerate severe distortion if it lasts less than 10 ms, DNR has considerable flexibility in the choice of detector attack time.

Attack time is only half the story. Once the detector has responded to a musical transient, it needs to decay back to the quiescent output level at the cessation of the transient. A slow decay time would mean that for a period following the end of the transient, the system audio bandwidth would still be relatively wide. The noise in this bandwidth would be unmasked and a noise "burst" heard at the end of each musical transient. Conversely, if the release time is short to ensure a rapid decrease in bandwidth, a loss in musical "ambience" will occur with the suppression of harmonics at

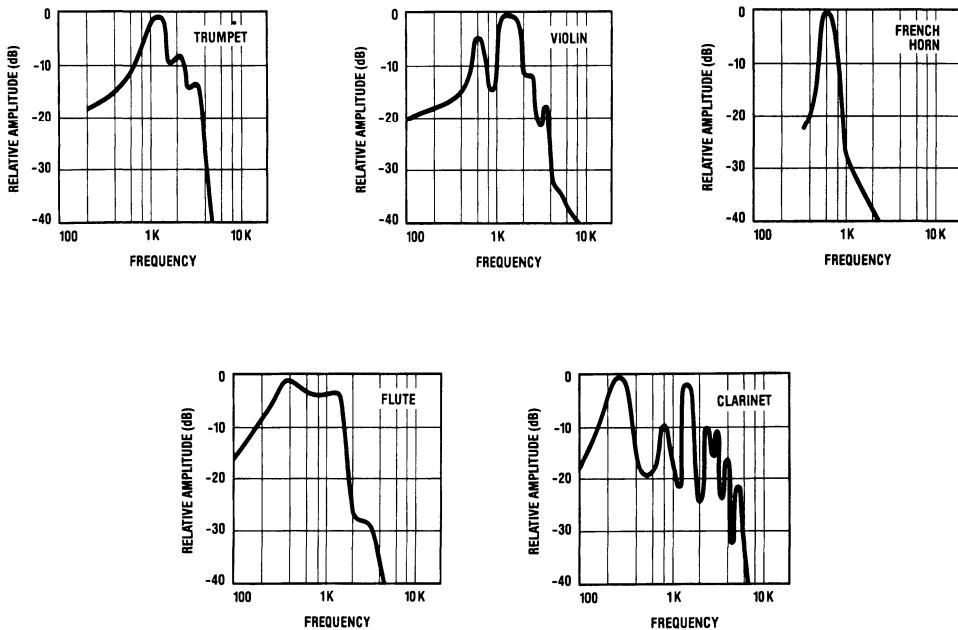


FIGURE 5. With Most Musical Instruments, As Well As Speech, Energy Is Concentrated around 1 kHz with a Rapid Fall-Off in Level above 6 kHz

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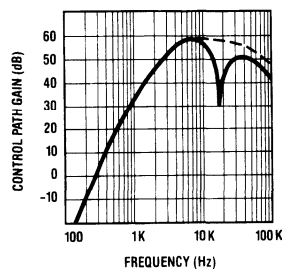
the end of a large signal transient. To avoid this, DNR uses a natural decay to within 10% of the final value in 60 ms. The inability of the ear to recover for 100 ms to 150 ms following a loud sound prevents the noise that is present (until the bandwidth is closed down) from being heard. Again a contrast with compander action is appropriate. As the DNR detector control voltage decays, the bandwidth starts to diminish. Initially only high frequencies are affected and since the harmonic amplitude of the signal is also decaying rapidly, the audio is unaffected by this decrease in bandwidth. For a compander however, as the control voltage decays, the system gain is altered—which also affects the signal mid-band and low frequency components. Thus, as with attack times, DNR is substantially less affected by the choice of release times, permitting a high tolerance in component values.

CIRCUIT OPERATION

The entire DNR system is contained within a single I/C and consists of two main functional signal paths. The audio path includes two low distortion low pass filters for a stereo audio source and the control path has a summing amplifier, variable gain filter amplifier and a peak detector. These functions are combined as shown in *Figure 7* which also shows the typical external components required for a complete n.r. system. By low distortion, we mean a filter that maintains the same cut-off slope and does not peak at the corner frequency as this frequency is changed. A 6 dB/octave filter slope was chosen since this provides a reasonable amount of noise reduction when the -3 dB frequency is less than 2 kHz and does not audibly affect the program material when the control path threshold is correctly set. It is possible to cascade the two audio filters—with a corresponding reduction in the size of the feedback capacitors to maintain the same operating frequency range—for a 12 dB/octave slope and up to 18 dB noise reduction. However, this steep-

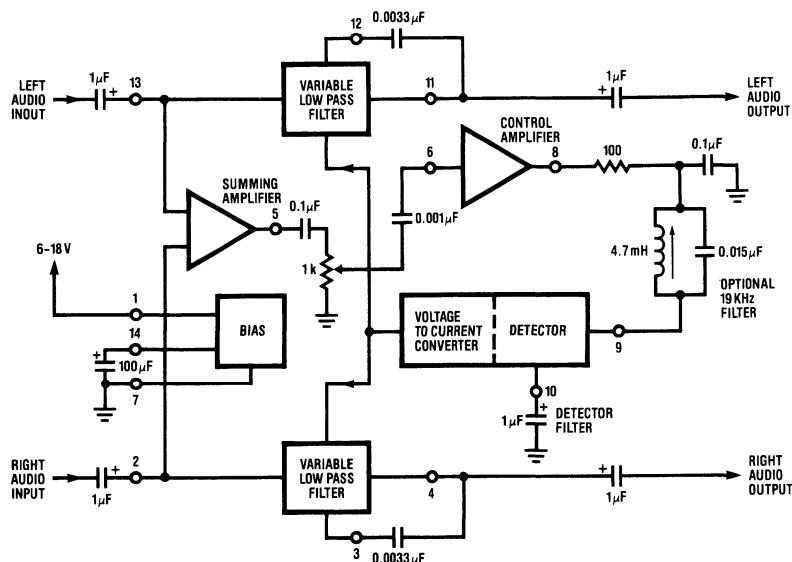
er roll-off characteristic is better suited for program material that is relatively deficient in high frequency content, early recordings or video tapes for example.

Each audio filter consists of a variable transconductance stage driving an amplifier with capacitive feedback. For a fixed capacitor value, as the transconductance is changed by the control signal, the open loop unity gain frequency is changed correspondingly, giving a variable corner frequency low-pass filter. Of particular importance in the design is the need to avoid voltage offsets at the filter output caused by control action, and the ability of the input stage to accommodate large signal swings without introducing distortion. Output offset voltages are not necessarily proportional to the change in control voltage but will, in any case, be accompanied by a significant change in the program level. Extensive listening tests have shown that offset voltages 26 dB or more below the nominal signal input level will not be heard. Overload capability is dependent on the input stage current level and the available supply voltage, but



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FIGURE 6. Control Path Characteristic (Including Optional 19 kHz Notch)



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FIGURE 7. The DNR System with Recommended Circuit Values

even with an 8 VDC supply the LM1894 can handle signals more than 20 dB over the nominal input level without increased distortion.

A summing amplifier is used at the input to the control path so that both left and right audio channels contribute to the control signal. Both audio filters are controlled with the same signal yielding matched audio bandwidths and maintaining a stable stereo image. From the summing amplifier the signal passes through a high-pass filter formed by the coupling capacitor and a 1 k Ω potentiometer. These components produce an amplitude roll-off below 1.6 kHz to avoid control path overload and help prevent high level, low frequency signals (drum beats for example) from activating the detector unnecessarily. The potentiometer provides a means to adjust the overall gain of the control path such that the input source noise level is able to just cross the detector threshold and begin opening the audio bandwidth. The correct adjustment point is one that permits alternate use and bypass of the DNR system with no audible change in the program material—other than reduction of background noise! Also, on more difficult program material where the S/N ratio is so poor that masking is not completely effective, the potentiometer can be set to limit the maximum audio bandwidth so that noise pumping is avoided. For systems with a predictable noise level such as cassette recorders, the potentiometer can be replaced by two suitable fixed resistors. Further filtering of the control signal is done at the input to the gain stage and at the input to the detector stage. The input capacitors to these stages form high pass filters with internal resistors and are cascaded for a combined corner frequency (-3 dB) of around 6 kHz. Finally the detector attack and release times are set to the previously described values by an external capacitor connected to the peak detector output.

This paper has described the DNR non-complementary noise reduction system in terms of the functional blocks and the psychocoustic background necessary to understand the operating principles. For a more complete circuit description and practical details on the use of the LM1894, see the data sheet and AN386. Note that DNR is a trademark of National Semiconductor Corporation and that use of the DNR logo is by license agreement only.

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- 9) 'On-chip Stereo Filter Cuts Noise Without Pre-processing Signal', Giles, Electronics, Aug., 1981.
- 10) 'A Non-Complementary Audio Noise Reduction System', Giles and Wright, IEEE Trans on Consumer Electronics, Vol. CE-27, # 4.

A Non-Complementary Audio Noise Reduction System

National Semiconductor
Application Note 386
Martin Giles



AN-386

INTRODUCTION

The popularity of companding or complementary noise reduction systems is self-evident. Nearly all medium to high quality cassette tape decks include either Dolby® B or Dolby C type noise reduction. A scant few have different systems such as dbx or Hi-Com. The universal appeal of companders to n.r. system designers is the amount of noise reduction they can offer, yet one of the major reasons the Dolby B system gained dominance in the consumer marketplace is because it offered only a limited degree of noise reduction — just 10 dB. This was sufficient to push cassette tape noise down to the level where it became acceptable in good-quality applications, yet wasn't enough that undecoded playback on machines not equipped with a Dolby B system was unsatisfactory — quite the contrary, in fact. The h.f. boost on Dolby B encoded tapes when reproduced on systems with modest speakers was frequently preferred. Since companding systems are so popular, it is not unreasonable to ask, "why do we need another noise reduction system?"

For many of the available audio sources today, companders are not a solution for audio noise. When the source material is not encoded in any way and has perceptible noise, complementary noise reduction is not possible. This includes radio and television broadcasts, the majority of video tapes and of course, older audio tape recordings and discs. The DNR™ single-ended n.r. system has been developed specifically to reduce noise in such sources. A single-ended system, able to provide noise reduction where non previously existed, and which avoids compatibility restraints or the imposition of yet another recording standard for consumer equipment, is therefore attractive.

The DNR system can be implemented by either of two integrated circuits, the LM1894 or the LM832, both of which can offer between 10 and 14 dB noise reduction in stereo pro-

gram material. Although differing in some details (the LM832 is designed for low-signal, low-supply voltage applications) the operation of the integrated circuits is essentially the same. Two basic principles are involved; that the noise output is proportional to the system bandwidth, and that the desired program material is capable of "masking" the noise when the signal-to-noise ratio is sufficiently high. DNR automatically and continuously changes the system bandwidth in response to the amplitude and frequency content of the program. Restricting the signal bandwidth to less than 1 kHz reduces the audible noise and a special spectral weighting filter in the control path ensures that the audio bandwidth in the signal path is always increased sufficiently to pass any music that may be present. Because of this ability to dynamically analyze the auditory masking qualities of the program material, DNR does not require the source to be encoded in any special way for noise reduction to be obtained. This paper deals with the design and operating characteristics of the LM1894. For a more complete description of the principles behind the DNR system, refer to AN384.

THE DNR SYSTEM FORMAT

A block diagram showing the basic format of the LM1894 is shown in Figure 1. This is a stereo system with the left and right channel audio signals each being processed by a controlled cut-off frequency ($f_{-3\text{dB}}$) low-pass filter. The filter cut-off frequency can be continuously and automatically adjusted between 800 Hz and 35 kHz by a signal developed in the control path. Both audio inputs contribute to the control path signal and are used to activate a peak detector which, in turn, changes the audio filters' cut-off frequency. The audio path filters are controlled by the same signal for equally matched bandwidths in order to maintain a stable stereo image.

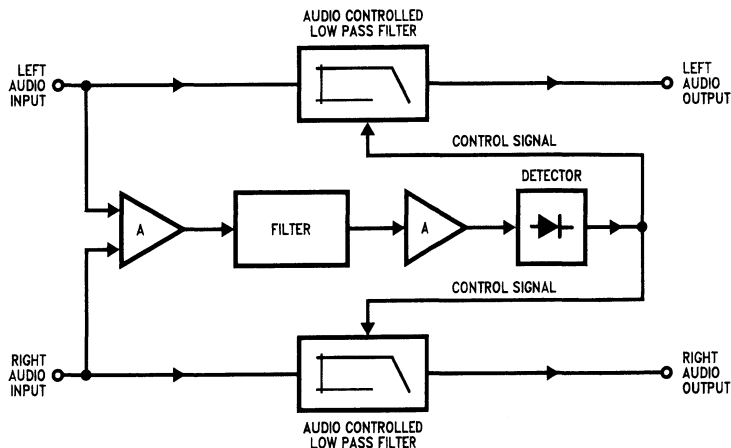
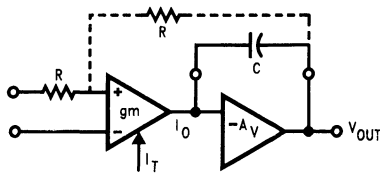


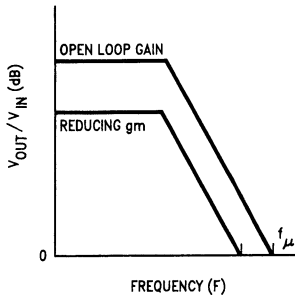
FIGURE 1. Stereo Noise Reduction System (DNR)

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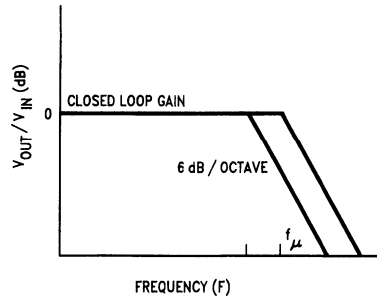
(a) Variable Lowpass Filter

TL/H/8395-2



(b) Open Loop Response

TL/H/8395-13



(c) Closed Loop Response

TL/H/8395-14

FIGURE 2

VARIABLE CUT-OFF LOW DISTORTION FILTERS

By low distortion we mean a filter that has a flat response below the cut-off frequency, a smooth, constant attenuation slope above the cut-off frequency and does not peak at the cut-off frequency as this frequency is changed.

The circuit topology is shown in Figure 2 (a) and is, in fact, very similar to the pole-splitting frequency compensation technique used on many integrated circuit operational amplifiers (see pp. 24-26 of "Intuitive I/C Op Amps" by T. M. Fredericksen). A variable transconductance (g_m) stage drives an amplifier configured as an integrator. The transconductance stage output current I_o is given by

$$I_o = g_m V_{in} \quad (1)$$

and if the second amplifier is considered ideal, then the voltage V_{out} is the result of I_o flowing through the capacitive reactance of C. Therefore we can write

$$V_{out} = \frac{I_o}{2\pi fC} \quad (2)$$

Combining (1) and (2) we have

$$\frac{V_{out}}{V_{in}} = \frac{g_m}{2\pi fC} \quad (3)$$

At some frequency, the open loop gain will fall to unity ($f = f_u$) given by

$$f_u = \frac{g_m}{2\pi C} \quad (4)$$

For a fixed value of capacitance, when the transconductance changes, then the unity gain frequency will change correspondingly as shown in Figure 2 (b).

If we put dc feedback around both stages for unity closed loop gain, the amplitude response will be flat (or unity gain) until f_u is reached, and then will follow the open loop gain curve which is falling at 6 dB/octave. Since we control g_m , we can make f_u any frequency we desire and therefore have a controlled cut-off frequency low pass filter.

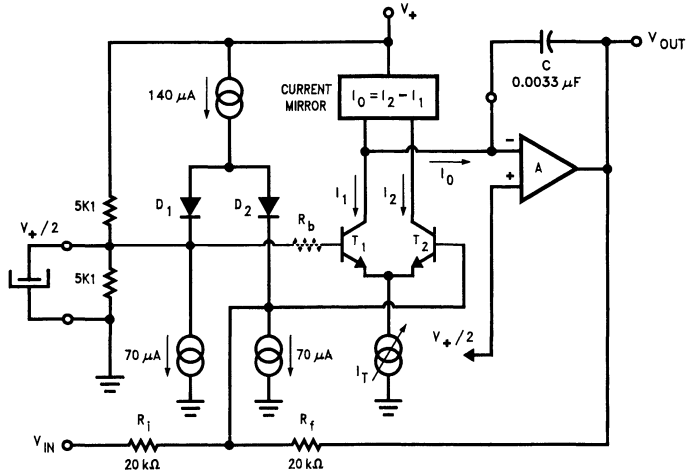
A more detailed schematic is given in Figure 3 and shows the resistors R_f and R_i which provide dc feedback around the circuit for unity closed-loop gain (i.e. at frequencies below f_u). The transconductance stage consists of a differential pair T_1 and T_2 with current mirrors replacing the more conventional load resistors. The output current I_o to the integrator stage is the difference between T_1 and T_2 collector currents.

For a differential pair, as long as the input differential voltage is small — a few millivolts — the g_m is dependent on the tail current I_T and can be written

$$g_m = \frac{q}{kT} \times \frac{I_T}{2} \quad (5)$$

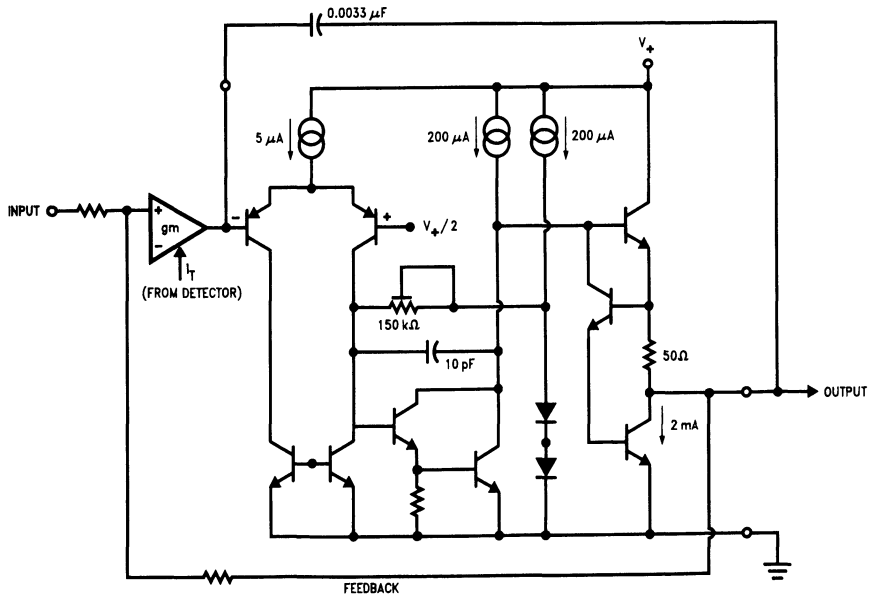
$$\text{where } \frac{q}{kT} = \frac{1}{26 \text{ mV}} \text{ @ } 25^\circ\text{C}$$

For frequencies below the cut-off frequency, the amplifier is operating closed loop, and the dc feedback via R_f will keep the input differential voltage very small. However, as the input signal frequency approaches cut-off, the loop gain decreases and larger differential voltages will start to appear across the bases of T_1 and T_2 . When this happens, the g_m is no longer linearly dependent on the tail current I_T and signal distortion will occur. To prevent this, two diodes D_1 and D_2 biased by current sources are added to the input stage. Now the signal current is converted to a logarithmically related voltage at the input to the differential pair T_1 and T_2 . Since the diodes and the transistors have identical geometries and temperature excursions, this conversion will exactly compensate for the exponential relationship between the input voltage to T_1 and T_2 and the output collector currents. As long as the signal current is less than the current available to the diodes, the transconductance amplifier will have a linear characteristic with very low distortion.



TL/H/8395-3

FIGURE 3. Variable Lowpass Filter with Distortion Correcting Diodes and Control Voltage Offset Compensation



TL/H/8395-4

FIGURE 4. The OP AMP Output Stage of the LM1894

For the entire circuit, if $R_i = R_f = R$ and the diode dynamic resistance is r_e , we can write the transfer characteristic as

$$\frac{V_{out}}{V_{in}} = \frac{-1}{\left(1 + \frac{4\pi fCK 26 \times 10^{-3}}{I_T}\right)} \quad (6)$$

$$\text{where } K = \left(2 + \frac{R}{2r_e}\right)$$

Therefore the pole frequency for $C = 0.0033 \mu F$ is

$$f_u = I_T / 4 \pi 26 \times 10^{-3} CK = I_T \times 33.2 \times 10^6$$

$$\text{for } f_u = 1 \text{ kHz, } I_T = 33.2 \mu A$$

$$\text{for } f_u = 35 \text{ kHz, } I_T = 1.1 \text{ mA}$$

In operation, the transconductance stage current I_T for the LM1894 will vary between the levels given above in response to the control path detected voltage. Notice that with the circuit values given in Figure 3 the maximum output voltage swing at the cut-off frequency is about IV_{rms} (use equation 2 and put $I_0 = I_T = 33 \mu A$) and this is specified in the LM1894 data sheet as the input voltage for 3% THD. This is, of course, the condition for minimum bandwidth when noise only is normally present at the input. When signals are simultaneously present causing the audio bandwidth to increase out to 35 kHz, the transconductance stage current is over 1 mA, allowing signal swings at 1 kHz (theoretically) of over $34 V_{rms}$. Practically, at maximum bandwidth the output swing is determined by the output stage saturation voltages which are dependent on the supply volt-

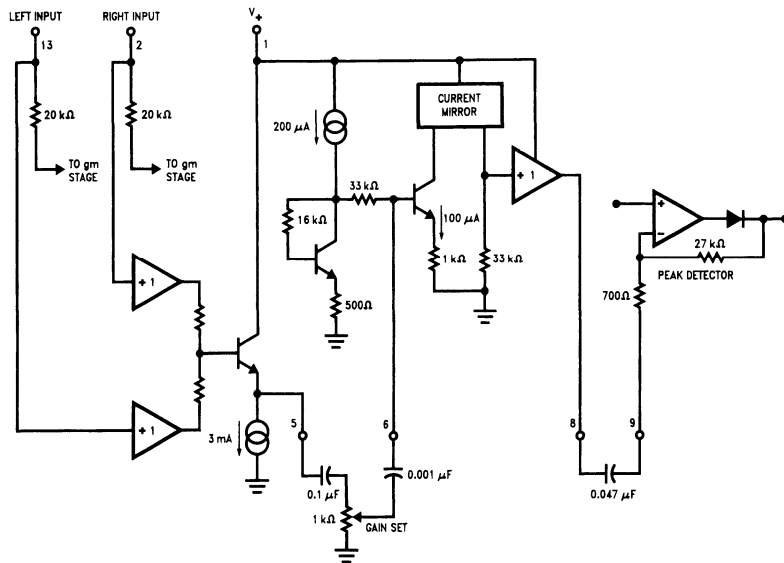


FIGURE 5. Control Path Amplifiers and Filters

TL/H/8395-5

age (see Figure 4). With a 15 V_{DC} supply, the LM1894 can handle well over 4 Vrms.

While there are other circuit topologies that can be used to obtain a variable cut-off low pass filter, this design has certain advantages, especially when it comes to avoiding control feedthrough. Control feedthrough is the name given to voltage offsets that can occur in the audio path as the transconductance stage current changes. The audible effect is a low level "bacon frying" noise or pops as the bandwidth changes. To prevent such voltage offsets occurring, the differential stage T₁ and T₂, the current mirrors and the diodes are arranged to provide good tracking over the entire range of the bandwidth control current I_T. Because the transconductance stage is driving the inverting input to an operational amplifier — a virtual ground — there will be no voltage swing at this node. This eliminates possible offset voltages from output impedance changes in the current mirror and T₁ collector caused by different operating currents. Last, but not least, a source of offset voltages are the base currents of T₁ and T₂. Because the transistors have a finite current gain, when the tail current I_T is increased, these base currents must increase slightly. T₁ base current is provided by the reference voltage (V₊/2), but T₂ base current must come via the feedback resistor R_f. This current is not normally available from D₂ because the feedback loop is holding T₁ and T₂ base voltages equal. By adding the resistor R_b in series with T₁ base, a compensating offset voltage is produced across the input diodes. This reduces the current in D₁ slightly and increases the current in D₂ correspondingly, allowing it to supply the increased base current requirement of T₂.

THE CONTROL PATH

The purpose of the control path is to ensure that the audio bandwidth is always sufficiently wide to pass the desired signal, yet in the absence of this signal will decrease rapidly enough that the noise also present does not become audible. In order to do this, the control path must recognize the masking qualities of the signal source and the detector stage must be able to take advantage of the characteristics

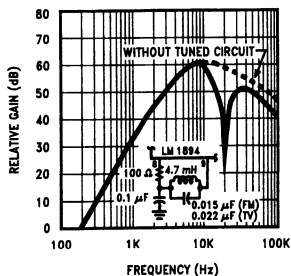
of the human ear so that audible signal distortion or unmasking does not occur.

Figure 5 shows a block diagram of the control path including the external components. A straight-forward summing amplifier combines the left and right channel inputs and acts as a buffer amplifier for the gain control. Because the noise level for signal sources can be different — cassette tapes are between -50 dB and -65 dB (depending on whether Dolby B encoding is employed) and FM broadcast noise is around -45 dB to over -75 dB (depending on signal strength) — the control path gain is adjusted such that a noise input is capable of just increasing the audio bandwidth from its minimum value. This ensures that any program material above the noise level increases the audio bandwidth so that the material is passed without distortion. Setting the potentiometer (or an equivalent pair of resistors) will be described in more detail later.

The gain control potentiometer is also part of the DNR filter characteristic derived from auditory masking considerations — see AN384. Combined with a 0.1 μF coupling capacitor, the total resistance of the potentiometer will cause a signal attenuation below 1.6 kHz.

$$\text{i.e. } f_1 = \frac{1}{2\pi RC} = \frac{1}{2\pi \times 10^3 \times 0.1 \times 10^{-6}} = 1.6 \text{ kHz}$$

This helps to prevent signals with a high amplitude but no high frequency content above 1 kHz — such as a bass drum — from activating the control path detector and unnecessarily opening the audio bandwidth. For signals that do have a significant high frequency content (predominantly harmonics), the control path sensitivity is increased at a 12 dB/octave rate. This rapid gain in sensitivity is important since the harmonic content of program material typically falls off quickly with increasing frequency. The 12 dB/octave slope is provided by cascading two RC high pass filters composed of the coupling capacitors to the control path gain stage and detector stage and the internal input resistors to these stages. Individual corner frequencies of 5.3 kHz and 4.8 kHz respectively are used, with a combined corner frequency around 6 kHz. Above 6 kHz the gain can be allowed to



TL/H/8395-6

FIGURE 6. Control Path Frequency Response

decrease again since the signal energy content between 1 kHz and 6 kHz (the critical masking frequency range) will have already caused the audio bandwidth to extend beyond 30 kHz, allowing passage of any high frequency components in the audio path.

Under some circumstances, not normal to music or speech, the source can contain relatively high level, high frequency components which are not necessarily accompanied by large levels of low frequency signal energy providing noise masking. These are spurious components such as the line scan frequency in a television receiver (15.734 kHz) or sub-carrier signals such as the 19 kHz pilot tone in FM stereo broadcasting. Although both these components should be low enough to be inaudible in the audio path, their presence in the control path could cause a change in the minimum bandwidth and hence the amount of available noise reduction. Since these unwanted components are at frequencies higher than the desired control path frequency range, they are easily accommodated by including a notch filter in the control path at the specified frequency. A resonant L-C circuit with a Q of 30 will attenuate 19 kHz by over 28 dB. If a 10% tolerance 0.015 μ F capacitor is used, the coil can be a fixed 4.7 mH inductance. For 15.734 kHz a 0.022 μ F capacitor is needed. When those frequency components are not present (i.e. in cassette tapes) the L-C circuit is eliminated and the gain amplifier and detector stage are coupled together with a single 0.047 μ F capacitor.

Apart from providing the proper frequency response the control path gain must be enough to ensure that the detector threshold can be reached by very low noise input levels. The summing amplifier has unity gain to the sum of the left and right channel inputs and the necessary signal gain of 60 dB is split between the following gain amplifier and the detector stage. For the gain amplifier

$$A_v = 33 \times 10^3 / (r_e + 10^3) = 26.2 \\ = 28.4 \text{ dB}$$

For the detector stage, the gain to negative signal swings is

$$A_v = 27 \times 10^3 / 700 = 38.6 = 31.7 \text{ dB}$$

With over 60 dB gain and typical source input noise levels, the gain potentiometer will normally be set with the wiper arm close to the ground terminal.

THE DETECTOR STAGE

The last part of the LM1894 to be described is the detector stage which includes a negative peak detector and a voltage to current converter. As noted earlier, the input resistance of the detector, together with the input coupling capacitor, forms part of the control path filter. Similarly the output resistance from the detector and the gain setting feedback resistor help to determine the detector time constants. With

a pulse or transient input signal, the rise time is 200 μ s to 90% of the final detected voltage level. Actual rise-times will normally be longer with the detector tracking the envelope of the combined left and right channel signals after they have passed through the control path filter.

An interesting difference to compandor performance can be demonstrated with a 10 kHz tone burst. Since the LM1894 detector responds only to negative signal peaks, it will take about four input cycles to reach 90% of the final voltage on the detector capacitor (this is the 500 μ s time constant called out in the data sheet). After the first two cycles the audio bandwidth will have already increased past 10 kHz and a comparison of the input and output tone bursts will show only a *slight* loss in amplitude in these initial cycles. A compandor, however, usually cannot afford a fast detector time constant since the rapid changes in system gain that occur when a transient signal is processed can easily cause modulation products to be developed which may not be treated complementarily on playback. Therefore there is a time lag before the system can change gain, which may be to the maximum signal compression (as much as 30 dB depending on the compandor type). Failure to compress immediately at the start of the tone burst means that an *overshoot* is present in the signal which can be up to 30 dB higher than the final amplitude. To prevent this overshoot from causing subsequent amplifier overload (which can last for several times the period of the overshoot), clippers are required in the signal path, limiting the dynamic range of the system. Obviously, the LM1894 does not need clippers since no signal overshoots in the audio path are possible.

When the input signal transient decays, the diode in the detector stage is back biased and the capacitor discharges primarily through the feedback resistor and takes about 60 ms to reach 90% of the final value.

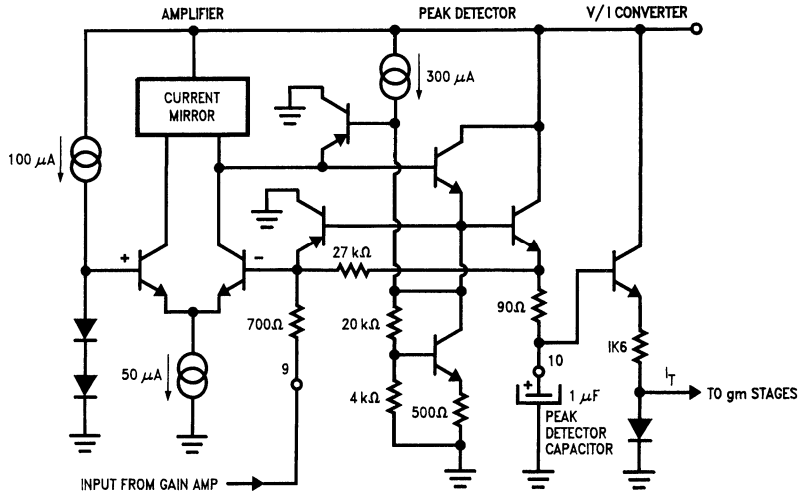
$$T = RC \times 2.3 = 27 \times 10^3 \times 1 \times 10^{-6} \times 2.3 \\ = 62.1 \text{ ms}$$

The decay time constant is required to protect the reverberatory or "ambience" qualities of the music. For material with a limited high frequency content or a particularly poor S/N ratio, some benefit can be obtained with a faster decay time—a resistor shunted across the detector capacitor will do this. Resistors less than 27 k Ω should not be used since very fast decay times will permit the detector to start tracking the signal frequency. For signal amplitudes that are not producing the full audio bandwidth, this will cause a rapid and audible modulation of the audio bandwidth.

BYPASSING THE SYSTEM

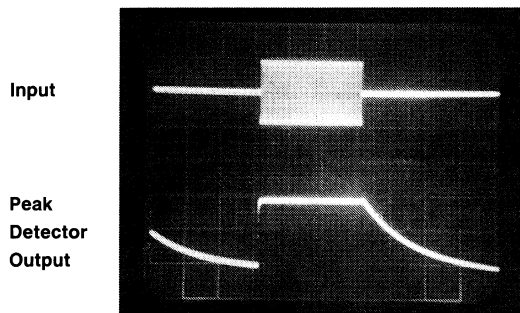
Sometimes it is necessary or desirable to bypass the n.r. system. This will allow a direct and instantaneous comparison of the effect that the system is having on the program material and will assist in arriving at the correct setting for the control path gain potentiometer. This facility is not practical with compandors unless unencoded passages occur in the program material. Also, should the action of the compandor become more objectionable than the noise in the original material, there is no way of switching the n.r. system off.

One way of bypassing is to simply use a double pole switch to route the signals around the LM1894. This physically ensures complete bypassing but does present a couple of problems. First, there may be a level change caused by the different impedances presented to the following audio stages when switching occurs. Second, the signal now has to be routed to the front panel where the switch is located, perhaps calling for shielded cable.



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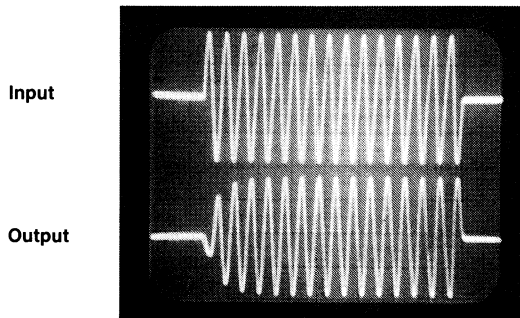
FIGURE 7. Peak Detector and Voltage to Current Converter



TL/H/8395-8

TIME: 20 ms/DIV

Peak Detector Response, 500 mV/Div



TL/H/8395-12

TIME: 0.5 ms/DIV

Audio Output Response, 10 kHz Tone Burst

FIGURE 8

A different technique, which avoids these problems, is to switch the LM1894 permanently into the full audio bandwidth mode. Since this provides a high S/N ratio path and low distortion the impact on the signal is minimal. Two methods can be used to switch the LM1894 audio bandwidth fully open, both with a single pole switch that is not in the audio path. Simply grounding the input of the peak detector amplifier will generate the maximum bandwidth control current and simultaneously prevent any control signals reaching the detector. Usually this is more than adequate since the maximum audio bandwidth is 34 kHz, but in some cases the 1 dB loss at 17 kHz produced by the single pole audio filters may not be desired. *Figure 9* shows a way to increase the audio bandwidth to 50 kHz (-1 dB at 25 kHz) by pulling up the detector capacitor to the reference voltage level ($V_+/2$) through a 1 k Ω resistor. This method is useful only for higher supply voltage applications. To increase the bandwidth significantly the detector capacitor must be pulled up to around 5V ($V_+ > 10V$). Although a separate voltage source other than the reference pin could be used when V_+ is less than 10V, this can cause an internal circuit latch-up if the voltage on the detector increases faster than the reference voltage at initial turn-on.

GENERAL SYSTEM MEASUREMENTS AND PRECAUTIONS

For most applications the external components shown in *Figure 9* will be required. In fact, the only recommended deviation from these values is the substitution of an equivalent pair of fixed resistors for the gain setting potentiometer. Location of the LM1894 in the audio path is important and should be prior to any tone or volume controls. In tape systems, right after the playback head pre-amplifier is the best place, or at the stereo decoder output (after de-emphasis and the multiplex filter) in an FM broadcast receiver. The LM1894 is designed for a nominal input level of 300 mVrms and sources with a much lower pre-amplifier output level will either require an additional gain block or substitution of the LM832 which is designed for 30 mVrms input levels.

The same circuit as *Figure 9* can be used for measurements on the I/C performance but, as with any other n.r. system, care in interpretation of the results may be necessary. For example, while the decay time constant for a tone burst signal is pretty constant, the attack time will depend on the tone frequency.

Sometimes separation of the audio path input and the control path is required, particularly when the frequency response or the THD with low input signal levels is being measured. If the audio and control paths are not separated then a typical audio system measurement of the frequency response will not appear as expected. This is because the control path frequency response is non-linear, exhibiting low sensitivity at low frequencies. When a low level input signal is swept through the audio frequency range, at low frequencies the audio -3 dB bandwidth will be held at 1 kHz, and the audio path signal will fall in amplitude as the signal goes above 1 kHz. As the signal frequency gets yet higher, the increasing sensitivity of the control path will allow the detector to be activated and the audio path -3 dB frequency starts to overtake the signal frequency. This causes the output signal amplitude to increase again giving the appearance that there is a dip in the audio frequency response around 1–2 kHz. It is worth remembering at this point that the audio path frequency response is always flat below some corner frequency and rolls off at 6 dB/octave above this frequency. In normal operation this corner frequency is the result of the aggregate control path signals in the 1 kHz to 6 kHz region and not the result of a single input frequency. To properly measure the frequency response of the audio path at a particular signal input frequency and amplitude, the control path input is separated by disconnecting C_5 from Pin 5 and injecting the signal through C_5 only. Then, a separate swept frequency response measurement can be made in the audio path. Similarly measurements of THD should include separation of the audio and control path inputs.

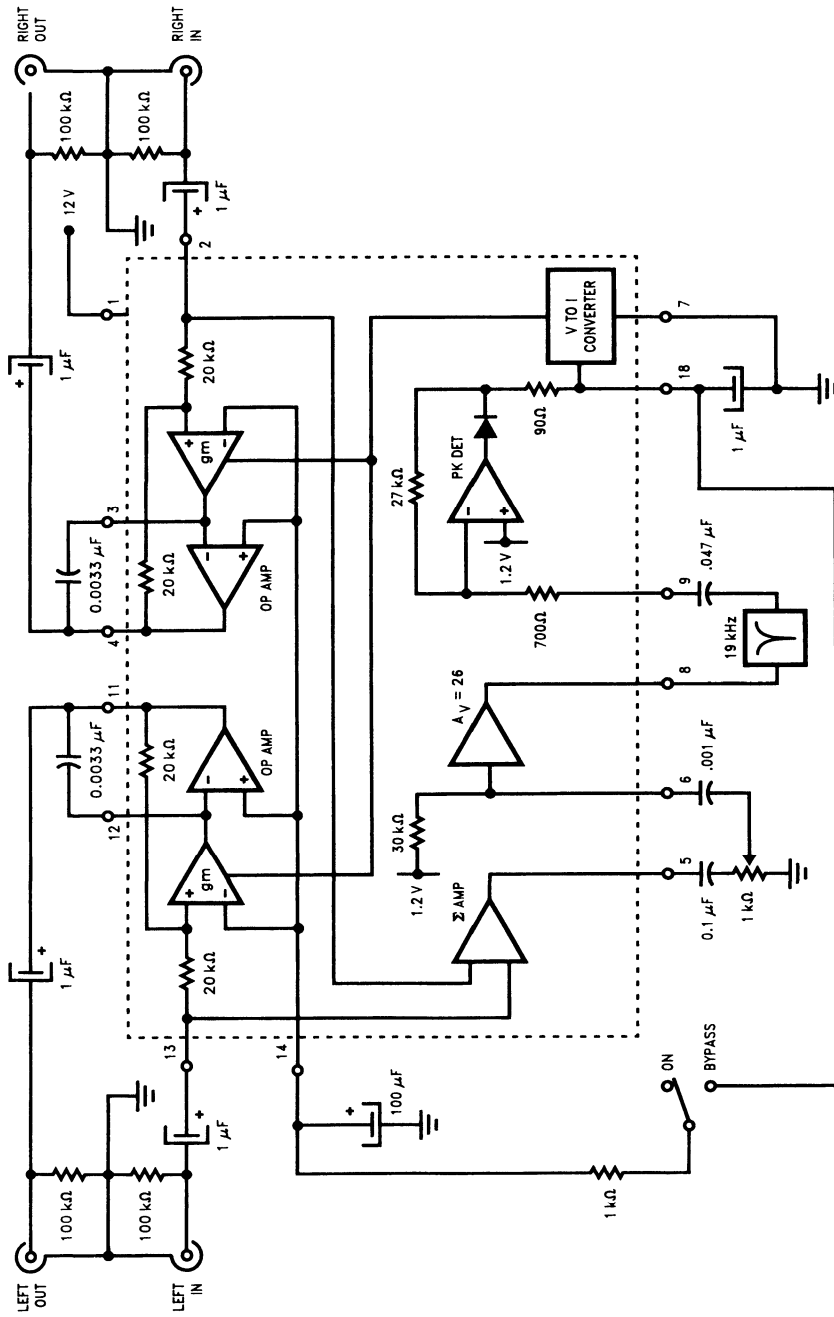


FIGURE 9. Complete Stereo Noise Reduction System

PITFALLS - OR WHAT TO LISTEN FOR

Many people are understandably wary of non-complementary n.r. systems since there is no perfect means for distinguishing between the desired signal and noise. A thorough understanding of the psycho-acoustic basis for noise masking will go a long way to allaying these fears, but a much simpler method is to listen to a variety of source material with a DNR system being switched in and out. Even so, improper implementation of the LM1894—wrong location in the audio path changing either the level or frequency response of the source—or incorrect external component values, or the wrong sensitivity setting, can all strongly affect the audio in an undesired way. Sometimes, unhappily, the source is really beyond repair and some compromise must be made. Phonograph discs with bad scratches may require special treatment (a click and pop remover) and some older tape recordings may show some or all of the following problems.

1) Pumping:

Incorrect selection of the control path bandwidth external components can result in an audible increase in noise as the input level changes. This is most likely to be heard on solo instruments or on speech. Sometimes the S/N rate is too poor and masking will not be completely effective - i.e., when the bandwidth is wide enough to pass the program material, the increase in noise is audible. Cutting down on the pumping will also affect the program material to some extent and judgement as to which is preferable is required. Sometimes a shorter decay time constant in the detector circuit will help, especially for a source which always shows these characteristics, but for better program material a return to the recommended detector characteristics is imperative.

2) High Frequency Loss:

This can be caused by an improper control path gain setting—perhaps deliberate because of the source S/N ratio as described above—or incorrect values for the audio path filter capacitors. Capacitors larger than the recommended values will scale the operating bandwidth lower, causing lower -3 dB corner frequencies for a given control path signal. Return to the correct capacitor values and the appropriate control path gain setting will *always* ensure that the h.f. content of the signal source is preserved.

3) Apparent High Frequency Loss:

The ability to instantaneously A/B the source with and without noise reduction can sometimes exhibit an apparent loss of h.f. signal content as the DNR system operates. This is most likely to happen with sources having an S/N ratio of less than 45 dB and is a subjective effect in that the program material probably does not have any significant h.f. components. It has been reported several times elsewhere that adding high frequency noise (hiss) to a music signal with a limited frequency range will seem to add to the h.f. content of the music. Trying sources with a higher S/N ratio that do not demonstrate this effect can re-assure the listener that the DNR system is operating properly. Alternatively a control path sensitivity can be used that leaves the audio bandwidth slightly wider, preserving the "h.f. content" at the expense of less noise reduction in the absence of music.

4) Sensitivity Setting:

Since this is the only adjustment in the system, it is the one most likely to cause problems. Improper settings can cause any of the previously described problems. Factory pre-sets can (and are) used, but only when the source is well defined with known noise level. For the user who intends to noise reduce a variety of sources, the control path gain potentiometer is required and should be adjusted for each application. A bypass switch is helpful in this respect since it allows rapid A/B comparison. Another useful aid is a bandwidth indicator, shown in *Figure 10*. This is simply an LED display driver, the LM3915, operating from the voltage on the detector filter capacitor at Pin 10 of the LM1894. The LM3915 will light successive LEDs for each 3 dB increase in voltage. The resistor values are chosen such that the capacitor voltage when the LM1894 is at minimum audio bandwidth, is just able to light the first LED, and a full audio bandwidth control signal will light the upper LED. Experience will show that adjusting the sensitivity so that the noise in the source (no signal is present) is just able to light the second LED, will produce good results. This display also provides constant reassurance that the system audio bandwidth really is adequate to process the music. A simpler detector, using a dual comparator and a couple of LEDs can be constructed instead, with threshold levels selected to show the correct sensitivity setting, minimum bandwidth, maximum bandwidth or some intermediate bandwidth as desired.

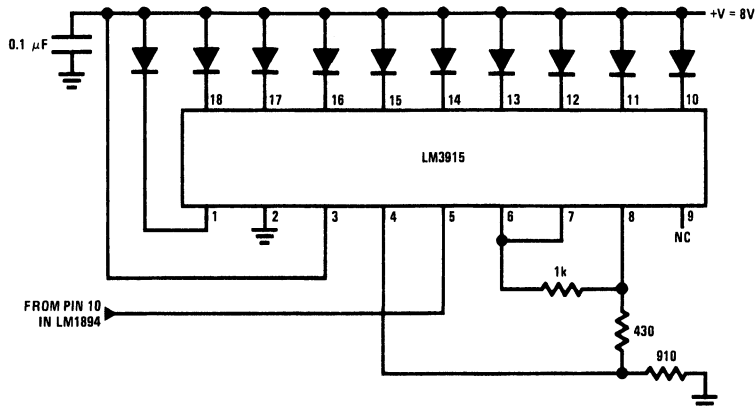


FIGURE 10. Bar Graph Display of Peak Detector Voltage

TL/H/8395-10

DNR Component Diagram

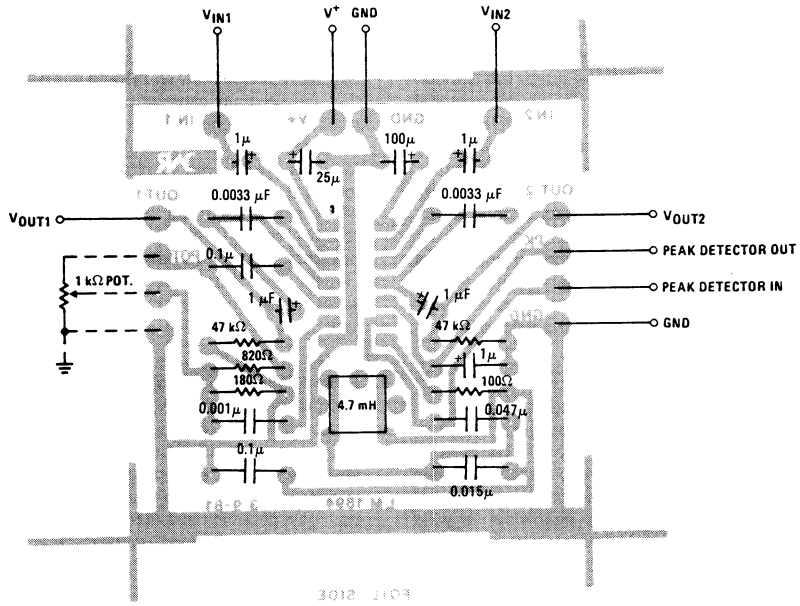


FIGURE 11. Printed Circuit Layout

TL/H/8395-11

DNR™ Applications of the LM1894

National Semiconductor
Application Note 390
Martin Giles
Kerry Lacanette



INTRODUCTION

The operating principles of a single-ended or non-complementary audio noise reduction system, DNR, have been covered extensively in a previous application note AN384, Audio Noise Reduction and Masking. Although the system was originally implemented with transconductance amplifiers (LM13600) and audio op-amps (LM387), dedicated I/Cs have since been developed to perform the DNR function. The LM1894 is designed to accommodate and noise reduce the line level signals encountered in video recorders, audio tape recorders, radio and television broadcast receivers, and automobile radio/cassette receivers. A companion device, the LM832, is designed to handle the lower signal levels available in low voltage portable audio equipment. This note deals chiefly with the practical aspects of using the LM1894, but the information given can also be applied to the LM832.

THE BASIC DNR APPLICATION CIRCUIT

At the time of writing, the LM1894 has already found use in a large variety of applications. These include:

- AUTOMOTIVE RADIOS
- TELEVISION RECEIVERS
- HOME MUSIC CENTERS
- PORTABLE STEREOS (BOOM BOXES)
- SATELLITE RECEIVERS
- AUDIO CASSETTE PLAYERS
- AVIONIC ENTERTAINMENT SYSTEMS
- HI-FI AUDIO ACCESSORIES
- BACKGROUND MUSIC SYSTEMS
- ETC.

In the majority of these applications the circuit used is identical to that shown in *Figure 1*, and this is the basic stereo Dynamic Noise Reduction System. Although a split power supply can be used, a single positive supply voltage is shown, with ac coupled inputs and outputs common in many consumer applications. This supply voltage can be between 4.5 V_{DC} and 18 V_{DC} but operation at the higher end of the range (above 8 V_{DC}) is preferred, since this will ensure adequate signal handling capability. The LM1894 is optimized for a nominal input signal level of 300 mVrms but with an 8 V_{DC} supply it can handle over 2.5 Vrms at full audio bandwidth. Smaller nominal signal levels can be processed but below 100 mVrms there may not be sufficient gain in the control path to activate the detector with the source noise. In this instance, and where battery powered operation is desired, the LM832 is a better choice. The LM832 has identical operating principles and a similar (but not identical) pin-out. It is optimized for input levels around 30 mVrms and a supply voltage range from 1.5 V_{DC} to 9.0 V_{DC}.

The capacitors connected at Pins 12 and 3 determine the range of -3 dB cut off frequencies for the audio path filters. Increasing the capacitor value scales the range downward - the minimum frequency becomes lower and the maximum or full bandwidth frequency will decrease proportionally. Similarly, smaller capacitors will raise the range.

$$f_{-3\text{dB}} = I_T / 9.1C \quad (I_T = 33 \mu\text{A MIN}) \quad (1)$$

$$(\quad = 1.05 \text{ mA MAX})$$

For normal audio applications the recommended value of 0.0033 μF should be adhered to, producing a frequency range from 1 kHz to 35 kHz.

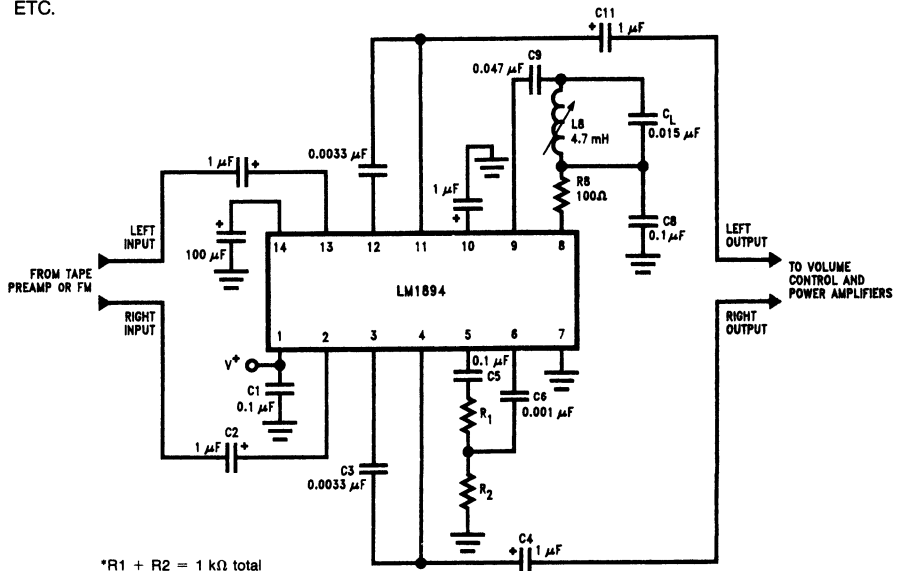
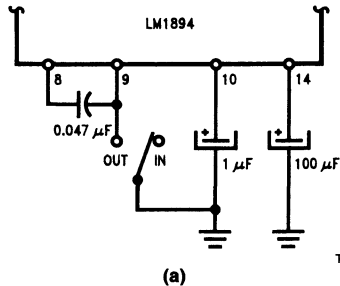
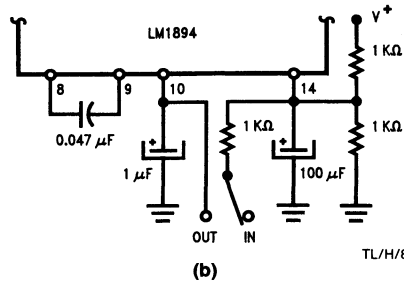


FIGURE 1. Complete DNR Application Circuit

TL/H/8420-1



TL/H/8420-2



TL/H/8420-18

FIGURE 2. Two Methods of DNR IN/OUT Switching

The two resistors connected at Pin 5 set the overall control path gain, and hence the system sensitivity. A lower tap point will decrease the sensitivity for high signal level sources, and a higher tap point will accommodate lower level sources. For purposes of initial calibration it is best to replace the resistors with a 1 k Ω potentiometer (the wiper arm connecting through C₆ to Pin 6), and follow the procedures outlined below. Once the correct adjustment point has been found, the position of the wiper arm is measured and an equivalent pair of resistors are used to replace the potentiometer. This, of course, can be done only if the source has a relatively fixed noise floor—the output from an audio cassette tape for example. For an add-on audio accessory the potentiometer should be retained as a front panel control to allow adjustment for individual sources. Use of DNR with multiple sources is described later.

SYSTEM CALIBRATION

System calibration can be performed in a number of ways. With the source connected play a blank but biased section of the cassette tape. Set the potentiometer so that the wiper arm is at ground and then steadily rotate it until a slight increase in the output noise level is heard. Alternatively, with source program material present, set the potentiometer with the wiper arm connected to the Pin 5 end of the slider and again rotate until the high frequency content of the program material appears to begin to be attenuated. Then return the potentiometer wiper slightly towards Pin 5 so that the music is unaffected.

A third method of adjustment can be done with an oscilloscope monitoring the voltage on the control path detector filter capacitor, Pin 10. This will show a steady dc voltage around 1V while the wiper arm of the potentiometer is at ground. As the wiper arm is rotated, this voltage will start to increase. About 200 mV above the quiescent value will usually be the right point. Note that this will not be a steady dc voltage but a random peak, low amplitude sawtooth waveform caused by peak detection of the source noise in the control path.

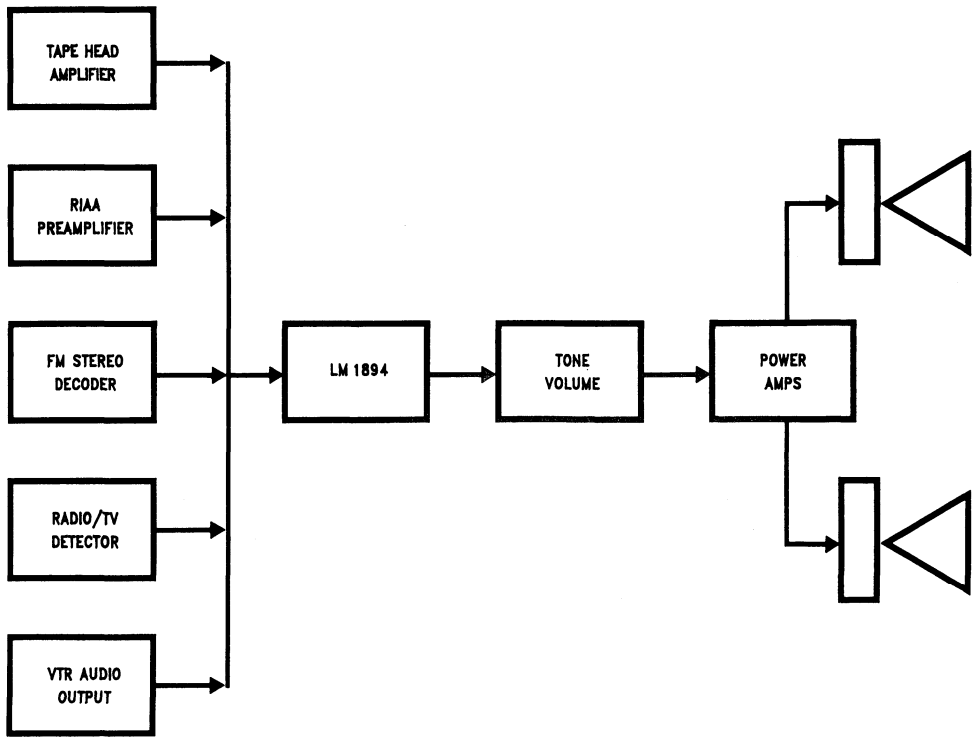
Whatever method is used to determine the potentiometer setting, this setting should be confirmed by listening to a variety of programs and comparing the audio quality while switching DNR in and out of the circuit. This is easily accomplished by grounding Pin 9 which will disable the control path and force the audio filters to maximum bandwidth, *Figure 2(a)*. Also shown is a second method of ON/OFF switching that gives an increased maximum bandwidth over that obtained in normal operation. Although the switch is not a required front panel control it can be an important feature. Unlike compander systems, DNR can be switched out leaving the source completely unprocessed in any way. With a switch, the user can always be assured that the noise reduction is not affecting the program material.

Apart from the basic circuit shown in *Figure 1*, all applications of the LM1894 in the signal chain. As *Figure 3* shows, the LM1894 is *always* placed right after the signal source pre-amplifier and *before* any circuit that includes user adjustable controls for volume or frequency response. The reasons for this are obvious. If the gain of the signal amplifier preceding DNR is changed arbitrarily, the noise input level to the LM1894 will not be at the correct point to begin activation of the audio path filters. Either reduced noise reduction will be obtained, or the high frequency content of the program material will be affected. A change in system gain prior to the LM1894 requires a corresponding change in the control path threshold sensitivity. Similarly modifying the frequency response, by heavy boost or cut of the mid to high frequencies, will have the same effect of changing the required threshold setting—apart from modifying the masking qualities of the program material.

HOW MUCH NOISE REDUCTION?

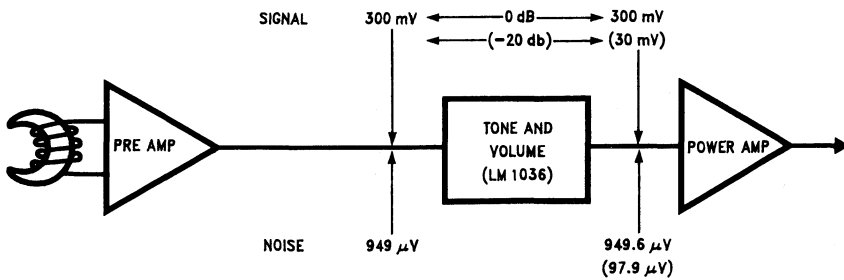
The actual sensitivity setting that is finally used, and the amount of noise reduction that is obtained, will depend on a number of factors. As the data sheet for the LM1894 and other application notes have explained in some detail, the noise reduction effect is obtained by audio bandwidth restriction with a pair of matched low-pass filters. A CCIR/ARM* weighted noise measurement is used so that the measured improvement obtained with DNR correlates well to the subjective impression of reduced noise. This is another way of stating that the source noise spectrum level versus frequency characteristic can have a large impact on how "noisy" we judge a source to be—and concomitantly how much of the "noisiness" can be reduced by decreasing the audio bandwidth. Fortunately most of the audio noise sources we deal with are smooth although not necessarily flat, resembling white noise. The weighting characteristic referred to above generally gives excellent correlation. For example, if the source -3 dB upper frequency limit is only 2 kHz (an AM radio), reducing the audio path bandwidth down to 800 Hz will improve the S/N ratio by only 5 to 7 dB. On the other hand, if the source bandwidth exceeds at least 8 kHz then from 10 dB to 14 dB noise reduction can be obtained. Of course, it is always worth remembering that this is the reduction in the source noise—any noise added in circuits *after* the LM1894 may contribute to the audible output and prevent the full noise reduction effect. To see how easily this can happen, we will consider the noise levels at various points in a typical automotive radio using an I/C tone and volume control, and an I/C power amplifier, both with and without noise reduction of the cassette player.

*See pp. 2-9 to 2-10, Audio Handbook, National Semiconductor 1980.



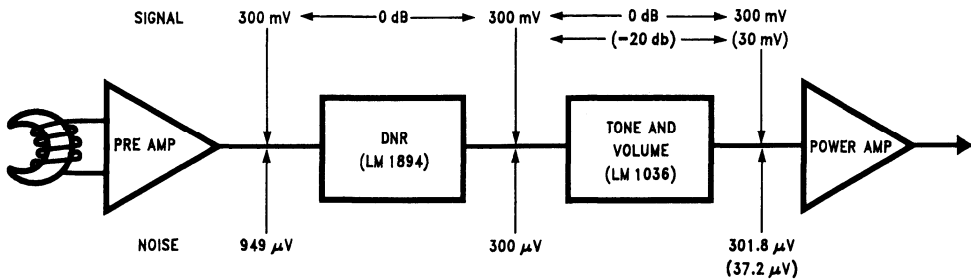
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FIGURE 3. Location of DNR in Audio Systems



TL/H/8420-19

(a) Without Noise Reduction



TL/H/8420-4

(b) With Noise Reduction

FIGURE 4. Signal and Noise Levels in the Audio Path

If we assume that the tape head pre-amplifier gain is such that the nominal output level (corresponding to 0"VU") is 300 mVrms, then for a typical cassette tape the noise will be 50 dB lower, or 949 μ V. The gain of the tone and volume control (an LM1036) is unity or 0 dB at maximum volume setting, with an output noise level of 33 μ V with no signal applied. With the tape pre-amplifier connected, the output noise from the LM1036 will be V_n where

$$V_n = 10^{-6} \sqrt{(33)^2 + (949)^2} = 949.6 \mu\text{V} \quad (2)$$

Clearly, the LM1036 has caused an insignificant increase in the background noise level (0.006 dB). Even when the volume control is set at -20 dB overall gain, the LM1036 intrinsic noise level is 22 μ V. The tape noise level is now 94.9 μ V (-20 dB) and the output noise V_n is

$$V_n = 10^{-6} \sqrt{(22)^2 + (94.9)^2} = 97.4 \mu\text{V} \quad (3)$$

Once more an insignificant contribution on the part of the LM1036 (0.23 dB).

Now we add noise reduction between the tape head amplifier and the LM1036. Usually this will mean over 10 dB reduction in the tape noise so that the input of the LM1036 sees 300 μ V noise. At 0 dB gain we have

$$V_n = 10^{-6} \sqrt{(33)^2 + (300)^2} = 301.8 \mu\text{V} \quad (4)$$

But at -20 dB

$$V_n = 10^{-6} \sqrt{(22)^2 + (30)^2} = 37.2 \mu\text{V} \quad (5)$$

When we compare the results of Equation (3) and (5) we see that at -20 dB gain setting we are getting only 8.4 dB noise reduction compared to 10 dB at maximum gain! Since the volume control is not normally set to maximum, this is a significant loss.

Active tone and volume controls are not the only circuits that can contribute to a loss in noise reduction. Most modern automotive radios use I/C power amplifiers delivering in excess of 6 watts into 4 Ω loads—and even more if bridge amplifiers are employed. With a 12 V_{DC} supply, the output signal swing is limited to less than 4 Vrms if clipping is avoided. Typical amplifiers have an input referred noise level of 2 μ Vrms, and with a gain of 40 dB (a typical value) the intrinsic output noise level is 200 μ Vrms, or 86 dB below clipping. For a normal listening level, the signal amplitude will be 20 dB below clipping which yields a S/N ratio of only 66 dB—which is just better than the noise reduced input to the amplifier.

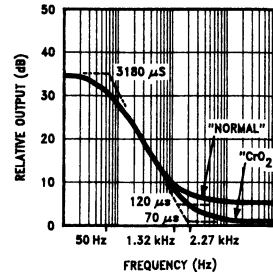
Many manufacturers recommend using I/C power amplifiers with gains of 60 dB. This will always result in unacceptable noise performance at moderate listening levels since the amplifier generated noise is now over 2 mV. For a signal 20 dB below clipping the output S/N ratio is only 46 dB!

It is interesting to note that the inclusion of just 10 dB noise reduction is sufficient to put pressure on the performance standards of the remaining circuits in the audio path of an automotive radio. If more noise reduction is available, such as a combination of Dolby B and DNR, or Dolby C, then the subsequent gain distribution must be considered even more carefully. The power amplifier gain may have to be reduced to 20 dB to avoid degrading the noise performance. In fact it may be impractical to realize the full noise performance capability of systems providing high levels of noise reduction in many automotive stereo radios.

MODIFICATIONS TO THE STANDARD APPLICATIONS CIRCUIT

1. TAPE DECKS WITH EQUALIZATION SWITCHES:

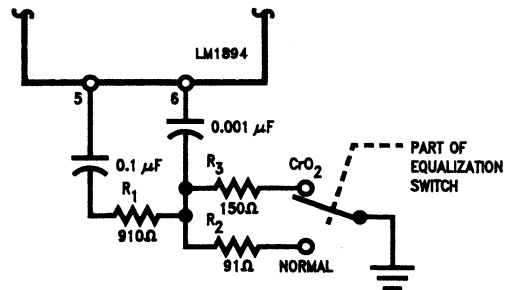
Many modern cassette tape decks and automotive radio cassette players offer at least two types of equalization in the head-preamplifier in order to optimize the frequency response of various tape formulations. These are often identified on the equalization switch as "Normal" and "CrO₂" corresponding to 120 μ s and 70 μ s time constants in the equalization network. This difference in time constants can mean that the noise floor from a cassette tape in the "CrO₂" mode can be up to 4 dB lower than for a tape requiring the "Normal" mode, *Figure 5*.



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FIGURE 5. Tape Playback Equalization Including Integration

Although a compromise setting can be found for the DNR threshold setting to accommodate both types of tape, a single pole, double throw switch ganged to the equalization switch will optimize performance for each mode. In the example given in *Figure 6*, the resistor values shown are from an application that yielded a 400 mVrms input to the LM1894 when the tape flux density was 200 nW/m. For different tape-head amplifiers the resistors R_1 and R_2 are selected using a "Normal" tape as a source, and then R_3 is selected according to the relationship given in Equation (5).



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FIGURE 6. Optimizing the Control Path Threshold for Different Tape Formulations

Notice that only one additional resistor is required over the standard application, and it is easy to substitute transistor switching in place of the spdt switch.

$$R_1/(R_1 + R_2) = 0.63 R_3/(R_1 + R_3) \quad (5)$$

2. TAPE DECKS WITH COMPLEMENTARY NOISE REDUCTION:

Most cassette decks available today employ some form of complementary (companding) noise reduction system, usually Dolby B Type. DNR can be used in conjunction with these noise reduction systems as a means to provide yet more noise reduction on decoded tapes and still provide

noise reduction for unencoded tapes. The LM1894 is located after the companding system and provision must be made for the drop in noise level when the compandor is being used. The DNR threshold sensitivity is increased by the appropriate amount so that the lower noise levels are still able to activate the audio filters. For example, the circuit in Figure 7 shows a switching arrangement to compensate for the 9 dB lower noise floor from a Dolby B decoded tape. Notice the change in resistor values R_1 through R_3 to raise the sensitivity (yet keeping the sum of R_1 and R_2 to 1k) and the 9 dB pad formed by the 3 k Ω resistor and the 1.5 k Ω resistor in parallel with the control path input Pin 6, for use when the compandor is switched off. Since the output level from the compandor is usually around 580 mV for a flux density of 200 nW/m, the ratio of R_1 to R_2 and R_3 is changed by only 5.6 dB compared to that shown in the previous Figure where the input level was 400 mVrms.

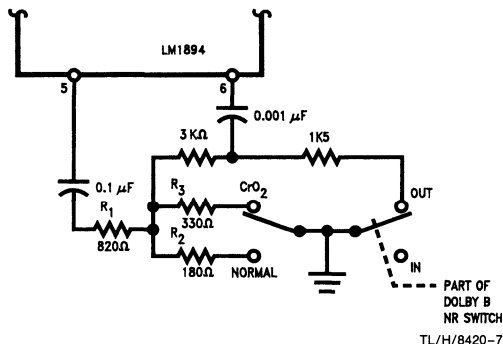


FIGURE 7. Switching with Other NR Systems

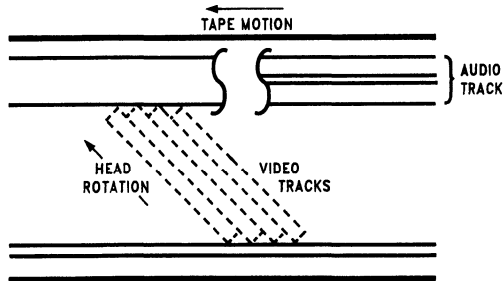


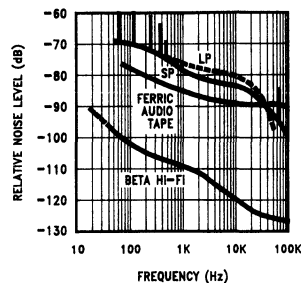
FIGURE 8. Video Magnetic Tape Format

3. VIDEO TAPE RECORDERS:

The audio track of a video cassette tape is similar to an audio cassette and appears along one edge of the tape. Although provision is made for two tracks, each 0.35 mm wide, a large number of recordings are monaural with a track width of 1 mm (0.04 inches).

Unlike the video heads, which are mounted on a rotating drum and angled to the direction of tape travel in order to give a much higher recording speed, the audio is recorded longitudinally with a separate head at 33.35 mm/sec for standard play, 16.88 mm/sec for long play, and 11.12 mm/sec for the very long play mode (VHS format tape machines). The noise spectrum is similar to an audio cassette but with a couple of differences. The typical frequency response from the head pre-amplifier does not extend beyond 10 kHz in the SP mode and is less in the LP and VLP modes. Even so, this bandwidth is enough to ensure the presence of the familiar tape "hiss" when played

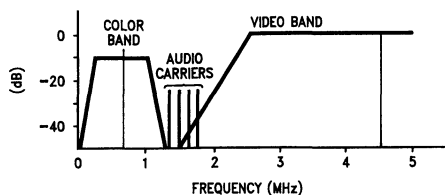
through modest or better Hi-Fi systems. Although the mono track width (twice as wide as an audio cassette stereo track) should help the S/N ratio, the slower tape speed does not, as shown in the curves of Figure 9. For the SP mode the S/N ratio is approximately 5 to 10 dB lower than the audio cassette and worsens by 3 to 5 dB in the extended play modes. Some "spurs" or "spikes" may be observed at harmonics of the video field frequency (60 Hz) and at the video line scan frequency of 15.734 kHz. The low frequency spikes will not affect DNR operation since the control path sensitivity decreases sharply below 1 kHz, but the presence of the 15.734 kHz component could cause improper sensitivity settings to be obtained. If this is the case, the pilot frequency notch filter for FM, described later, can be returned by changing the capacitor from 0.015 μ F to 0.022 μ F.



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FIGURE 9. Video Tape Noise Spectrum Levels

Figure 9 also shows the noise spectrum with the new Beta Hi-Fi format. This is clearly superior to both the standard format and audio cassette tapes and is realized by using the two video record/play heads simultaneously for audio, thus taking advantage of the substantially higher relative tape speed. The audio is added in the form of four FM carriers, Figure 10. Four carriers are necessary for two audio channels since the azimuth loss between the heads at video frequencies) is not enough at the lower audio carrier frequencies. Each head therefore uses different carriers for the left and right channel signals.



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FIGURE 10. Beta Hi-Fi Carrier Frequencies

A quite different technique is used for VHS Hi-Fi, which is similar to that for 8 mm video. Separate audio heads are mounted on the same rotating drum that is carrying the video heads, but with a much larger azimuth angle compared to the video heads. The sound signal is written deep into the tape coating and then written over by the video signal which causes partial erasure of the audio—about a 10 dB to 15 dB loss. The difference in azimuth angle prevents crosstalk and the much greater writing speed still yields an S/N of over 80 dB.

Both Hi-Fi formats provide excellent sound quality with hardly any need for noise reduction but DNR can still play a role. Conventionally recorded tapes are and will be popular for quite a while, and even with Hi-Fi recording capability much

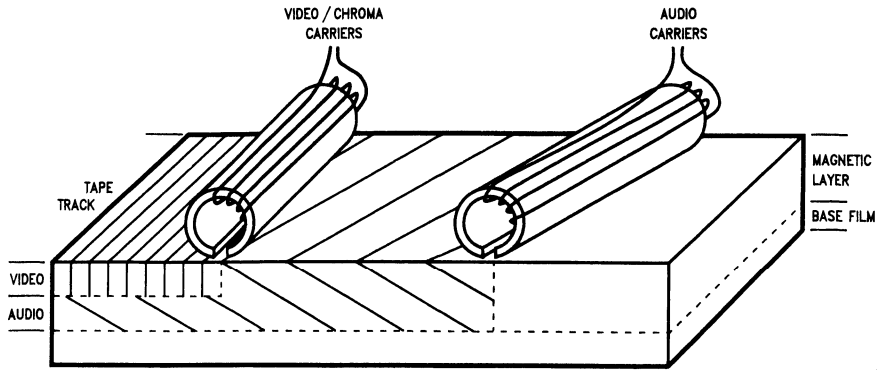


FIGURE 11. VHS Hi-Fi Recording Format

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recording will be done with television sound as a source—and the source noise will dominate now instead of the tape noise. As discussed later, DNR can be very effective in dealing with television S/N ratios, allowing much of the benefit of improved recording techniques to be enjoyed.

4. FM RADIOS:

FM sources can present special problems to DNR users. The presence of the 19 kHz stereo pilot tone can be detected in the DNR control path and cause improper threshold settings (the problem is not so much that the 19 kHz tone gives the wrong setting, but that if the threshold is adjusted with the tone present, then the threshold is wrong when the tone is absent—as in a monaural broadcast). Secondly, for FM broadcasts the noise level at the receiver detector output is dependent on the r.f. field strength when this field strength is under $100 \mu\text{V}/\text{meter}$ at the antenna terminal. With a fixed DNR threshold, as the noise level increases with decreasing field strength, the minimum audio bandwidth becomes wider and a loss in noise reduction is perceived. This latter problem occurs primarily with automobile radios where the signal strength can vary dramatically as the radio moves about. For the home receiver, re-adjustment of the DNR threshold setting for an individual station will compensate for the weaker signals.

To understand how much the pilot tone can affect the DNR control path, we can take a look at some typical signal levels. For an FM broadcast in the U.S., the maximum carrier deviation is limited to $\pm 75 \text{ kHz}$ with a pilot deviation that is 10% of this value. A high quality FM I/C such as the LM1865 will produce a 390 mVrms output at the detector with this peak deviation, so the pilot level at 19 kHz will be 39 mVrms. If the receiver does not include a multiplex filter, after de-emphasis 4 mV will appear at the inputs to the LM1894. Typically for FM signal noise floors, the resistive divider at Pin 5 will attenuate the pilot by 20 dB leaving 0.4 mVrms at Pin 6. This input level to the LM1894 control path is sufficient to cause the audio bandwidth to increase by over 1 kHz compared to the monaural minimum bandwidth. Of course, if the receiver does have a multiplex filter, which is common in high quality equipment or receivers that include Dolby B Type noise reduction, this problem will not happen, but otherwise we require an extra 15 dB to 20 dB attenuation at 19 kHz. This is obtained with a notch filter tuned to the pilot frequency connected between Pins 8 and 9 of the LM1894. Although a tuned inductor is shown, a fixed coil of similar inductance and Q can be used since with

normal component value tolerances ($\pm 7\%$ inductance, $\pm 10\%$ capacitance) the pilot tone will be attenuated by at least 15 dB.

Handling the signal strength dependence of the FM signal noise floor is not quite as easy — at least if pre-set DNR sensitivity settings are used. A look at the quieting curves for an FM radio will show why. At strong signal levels, greater than 1 mV/meter field strength at the antenna, the IF amplifier of the radio is in full limiting and the noise floor is between 60 dB and 80 dB below the audio signal. However, as the field strength starts to decrease below 1 mV/meter, the noise level begins to increase, even though the IF amplifier is still in limiting. Worse yet, since the demodulated output includes the noise from the stereo difference signal channel (L-R), the noise level is increasing more rapidly in the stereo mode than in the monaural mode. By the time the field strength has fallen to $100 \mu\text{V}/\text{m}$ the stereo noise is over 20 dB higher than the equivalent mono noise. If the DNR sensitivity is pre-set such that noise at the -45 dB to -55 dB level is activating the control path detector, when weaker stations are tuned in the noise level will increase and less noise reduction will be obtained. On the other hand, for stronger stations the noise level will drop below the detector threshold and a possibility exists that high frequency signals will be attenuated. Fortunately this latter occurrence is unlikely with commercial FM broadcasts since substantial signal compression is common, and the relatively high mid-band signals will be adequate enough to open the audio bandwidth sufficiently. In any event, with very strong r.f. signals, the need for noise reduction is minimal and DNR can be switched out.

	FM	TV
L	4.7 mH	4.7 mH
C	0.015 μF	0.022 μF

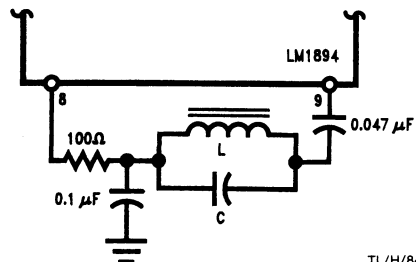
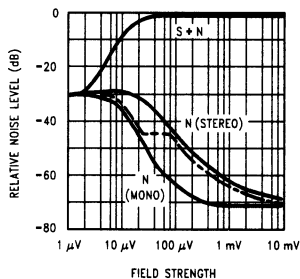


FIGURE 12. Control Path Notch Filter

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Recognizing that a fixed threshold setting is necessarily a compromise for FM, the designer can still elect to use a pre-set adjustment for convenience. The set-up procedure is a little more complicated than for an audio tape source and involves the use of an FM signal generator. The carrier frequency from the generator (between 88 MHz and 108 MHz) is unmodulated except for the stereo pilot tone, and the receiver is tuned to this carrier frequency. Then the carrier level is increased until the stereo demodulator output S/N ratio is that desired for the DNR threshold setting. For example, if the recovered audio output is 390 mVrms for 75 kHz deviation of the carrier frequency, the stereo noise level is 2.2 mVrms for a 45 dB S/N ratio. The generator level is increased until this noise voltage is measured at the demodulator output and the resistive divider at Pin 5 of the LM1894 adjusted correspondingly. A multiplex filter should be inserted between the decoder output and the S/N meter to prevent the pilot tone from giving an erroneous reading. At no time should the pilot tone be switched off since this will allow the decoder to switch into the monaural mode, decreasing the noise level -65 dB instead. A S/N ratio of 45 dB is chosen since many modern receivers incorporate blending stereo demodulators. As the dashed curve of *Figure 13* shows, when the stereo S/N ratio falls to 45 dB, the decoder starts to blend into monaural operation, thus keeping a constant S/N ratio. The loss in stereo separation that inevitably accompanies this blending is far less objectionable than abrupt switching from stereo to mono operation at weak signal levels.



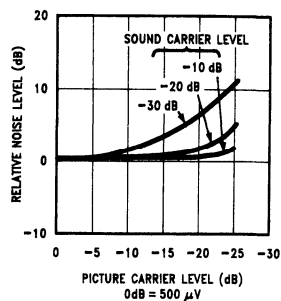
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FIGURE 13. FM Radio Quieting Curves

5. TELEVISION RECEIVERS:

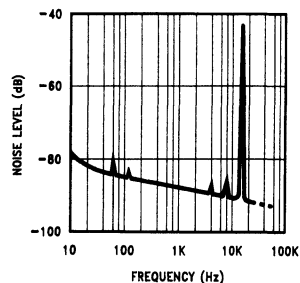
At first it might be thought that television broadcast signals, with an FM sound carrier located 4.5 MHz above the picture carrier frequency, will present the same difficulties as FM radio broadcasts to a DNR system with a pre-set threshold. This conclusion is modified by two considerations. First the TV receiver is unlikely to be mobile and the received signal strength will be relatively constant from an individual broadcast station. Secondly another subjective factor, the picture quality, will largely determine whether the signal strength is adequate enough for the viewer to stay tuned to that station. A representative television receiver will have a VHF Noise Figure between 6 dB and 7 dB such that, with a 75Ω antenna impedance, the picture will be judged noise-free at an input signal level of just above 0.5 mVrms - i.e. a picture signal to noise ratio of 43 dB. Noise will become perceptible to most viewers at a S/N ratio of 38 dB and become objectionable at 28 dB to 30 dB. Therefore 13 dB below 1 mVrms the picture noise is objectionable, and at -25 dB to -30 dB it will probably be totally unacceptable to the majority of viewers. For off-air broadcasts, the audio carrier ampli-

tude is 7 dB to 10 dB below the picture carrier amplitude and for cable services the typical sound/picture carrier ratio is -15 dB. However, due to the FM improvement factor (45.4 dB for equal amplitude carriers compared to the AM picture carrier) audio S/N ratios do not degrade as rapidly as the picture S/N—even with the lower audio carrier amplitudes. *Figure 14* shows the increase in audio noise level as both carrier amplitudes are reduced from the picture carrier level that produces a noise-free picture. When the picture noise is already objectionable the audio noise level has remained virtually unchanged, even for an audio carrier 30 dB below the picture carrier. By the time an unacceptable picture noise level has been reached, the audio noise has increased by less than 3 dB for sound carriers at -10 dB and -20 dB relative to the picture carrier. Therefore it is unlikely that a perceptible increase in noise compared to a strong channel will occur before the viewer switches to another channel.



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FIGURE 14. Increase in Audio Noise with Decreasing Carrier Levels



TL/H/8420-15

FIGURE 15. TV Noise Spectrum Level

Figure 15 shows the noise spectrum level of a strong audio carrier (1 mVrms) referred to 7.5 kHz carrier deviation. The standard peak deviation in the U.S. is 25 kHz so that the spectrum level will be 10 dB lower when referred to the peak audio level, meaning that the noise is not much better than the cassette tape noise levels shown previously. Only the relatively small power capability and limited bandwidth of audio amplifiers and speakers in conventional receivers has made this noise level acceptable. Unfortunately for the listener who hooks up the audio to his Hi-Fi system, or buys a new receiver with wider audio bandwidth and high output power (in anticipation of the proposed BTSC stereo audio broadcasts for television), TV sound will exhibit this noise.

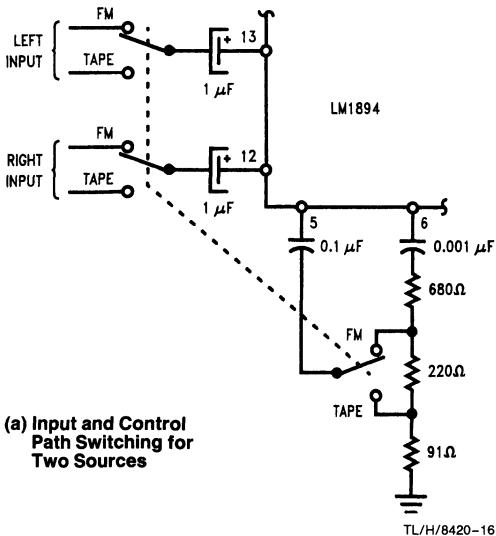
Because the noise floor will be relatively constant, a pre-set threshold can be used for the LM1894 control path (although broadcast of older movies with unprocessed and noisy optical soundtracks might increase the received noise), and the only modification to the standard application circuit is to shift the control path notch filter down to 15.734 kHz. This is done with sufficient accuracy simply by changing the 0.015 μF tuning capacitor to 0.022 μF .

Note: The introduction of a stereo audio broadcast (the BTSC-MCS proposal) does not substantially modify the above conclusions, even though dbx noise processing is used. The dbx-TV noise reduction is applied only to the new stereo difference signal channel (L-R) to decrease the additional noise intrinsic in the use of an AM subcarrier along with the normal (L+R) monaural channel. This means that the new stereo signal should have roughly the same characteristics as the present monaural signal.

6. MULTIPLE SOURCES:

Multiple sources are best accommodated by keeping the potentiometer in the LM1894 control path and allowing the user to optimize each source. Nevertheless, for convenience, pre-sets are often desired and these can be done in two ways.

- 1) If the sources have widely different S/N ratios, the resistive divider at Pin 5 should be tapped at the appropriate point for each source noise level. This assumes that the source signal levels have been matched at the input to the LM1894 for equal volume levels.
- 2) If the source S/N ratios are not too far different, then the input levels can be trimmed individually to produce the same noise level in the LM1894 control path. A single sensitivity setting is used, and an additional switch pole gated to the source selector switch is avoided.



Examples of both arrangements are shown in Figure 16(a) and (b). To set up the multiple source system of 16(b), the DNR control path sensitivity is adjusted for the source with the lowest noise floor. Measure the peak detector voltage (Pin 10) produced by this noise source and then switch to the next source. Adjust (attenuate) the input level of the new source to match the previous Pin 10 detector voltage and repeat this procedure for each subsequent source.

7. CASCADING THE LM1894 AUDIO FILTERS

The LM1894 has two matched audio lowpass filters which can be cascaded, providing a single channel filter per I/C with a 12 dB/octave roll-off. This produces slightly more noise reduction (up to 18 dB) but because the steeper filter slope may in some cases produce audible effects on high frequency material, cascaded filters are best used for sources with a relatively restricted h.f. content. When the filters are cascaded the combined corner frequency decreases by 64% according to Equation (6), for $n = 2$

$$f_c = f_0 \sqrt{10^{0.3/n} - 1} \quad (6)$$

Therefore, to retain the original frequency range, the capacitor values must be reduced by the same factor to 0.0022 μF . One of the audio outputs is connected over to the other audio filter input and the summing amplifier in the control path is by-passed by moving the 0.1 μF coupling capacitor from Pin 5 over to the single audio input. If the audio source is unable to drive the 1 k Ω impedance of the control path input network, this can be scaled up by using a 0.01 μF capacitor and a 10 k Ω potentiometer.

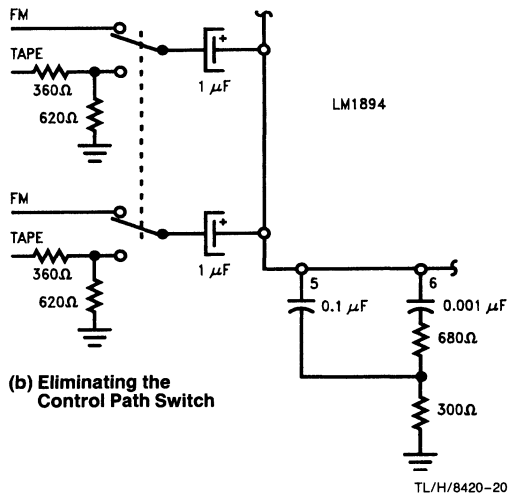


FIGURE 16. Multiple Programme Source Switching

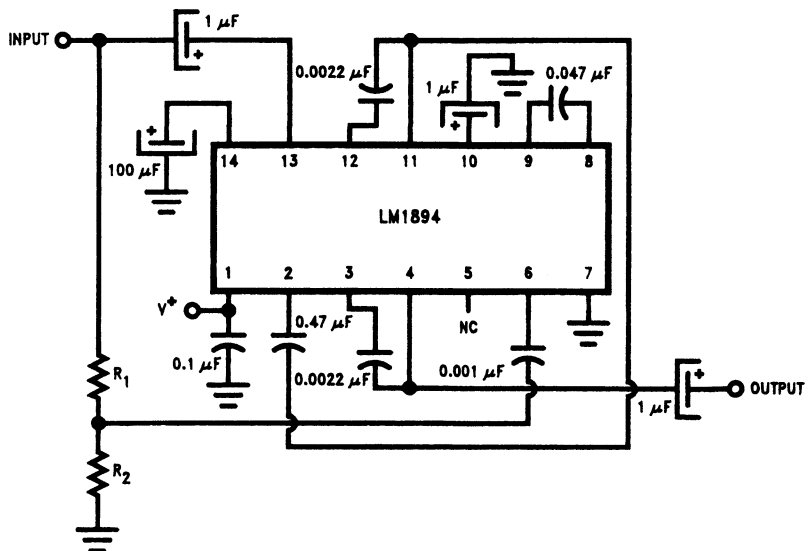


FIGURE 17. Cascading the Audio Filters of the LM1894

TL/H/8420-17

The LM1823: A High Quality TV Video I.F. Amplifier and Synchronous Detector for Cable Receivers

National Semiconductor
Application Note 391
Martin Giles



INTRODUCTION

The LM1823 is a video I.F. amplifier designed to operate at intermediate carrier frequencies up to 70 MHz, and employ phase locked loops for synchronous detection of amplitude modulation on these carrier frequencies. The high gain, wide AGC range and low noise of the LM1823 make it ideal for use in television receivers, video cassette recorders and in cable TV set-top converters requiring high quality detected base-band video and an audio intercarrier. Typical performance characteristics and features of this I/C are summarized in Table I below.

TABLE I

Maximum system operating frequency	70 MHz
Typical I.F. amplifier Gain (45.75 MHz)	> 60 dB
I.F. amplifier gain control range	55 dB
True synchronous detector with a PLL	
Detector conversion gain	34 dB
Detector output bandwidth	9 MHz
Detector differential gain	2%
Detector differential phase	1 degree
Noise averaged AGC system	
Internal AGC gated comparator	
Reverse tuner AGC output	
DC controlled video detection phase	
AFC detector	

THE R.F. SIGNAL FORMAT

Despite the wide variety of signal sources available to the home television receiver—broadcast, cable, satellite, video games etc.—on channel carrier frequencies from 55.25 MHz to 885.25 MHz, the spectral content of each R.F. channel has been established for many years. In the United States the channel bandwidth is fixed at 6 MHz with the picture carrier located 1.25 MHz from the lower end of the band, and an aural carrier placed 4.5 MHz above the picture (pix) carrier. Introduction of color television in the early fifties added another carrier, the chroma sub-carrier, positioned 3.58 MHz above the pix carrier frequency. The pix carrier is amplitude modulated* by the baseband video signal (which

* A more appropriate term is "negative downward modulation" since any modulating signal causes a decrease in the peak carrier amplitude (compared to conventional a.m., where the modulating signal alternately increases and decreases the peak carrier level with the mean carrier level remaining constant). For television carriers, syncs correspond to peak carrier and increasing brightness causes decreasing carrier amplitudes.

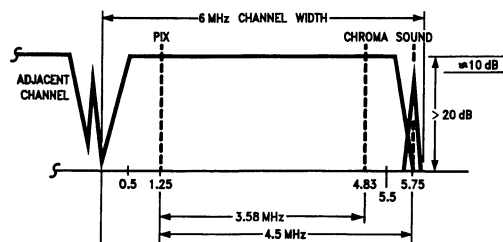
includes the synchronization information and the phase and amplitude modulated chroma subcarrier) while the aural carrier is frequency modulated. Television channels in Europe use similar carriers with the refinement of a fluctuating chroma subcarrier phase (P.A.L.).

The signal coming into the receiver has this general format and the receiver R.F. and I.F. circuits are designed to handle such a signal and reduce it back to the baseband composite video and audio intercarrier. Even where signal scrambling is used to protect the video modulation from unauthorized detection, the R.F. spectrum must remain within this format. For satellite broadcasts with frequency modulation of the video signal, the signal is demodulated and then remodulated onto a low VHF channel for reception by standard television receivers. In connection with this, the LM1823 PLL detector is not suitable for wide-band FM detection—even though the I.F. carrier (70 MHz) is well within the LM1823 I.F. amplifier frequency capability.

Notice again that the pix carrier is located at one end of the occupied bandwidth and only the upper sidebands are being fully transmitted. The lower sidebands are truncated with only frequencies close to the pix carrier frequency modulating the carrier. This method of conserving the frequency spectrum is referred to as vestigial sideband transmission.

THE CABLE CONNECTION

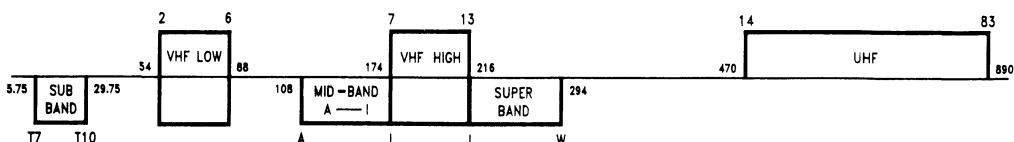
Originally introduced many years ago as a means for providing broadcast TV to isolated areas or where the terrain made direct reception difficult, cable TV had modest growth in the U.S. and was a stagnating industry until the mid-seventies. Lower cost satellite earth stations were the turning point, allowing cable operators access to many varied program sources from any part of the country.



TL/H/8421-1

FIGURE 1. U.S. Broadcast Channel Spectrum

Broadcast Channel Frequency Allocations



Cable Channel Frequency Allocations

TL/H/8421-2

FIGURE 2. Broadcast and Cable Bands in the U.S.

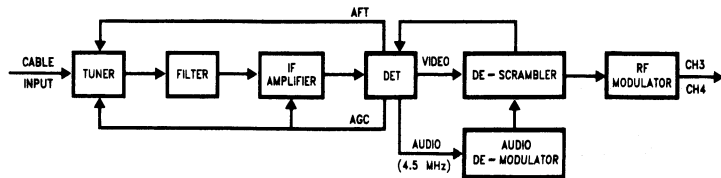


FIGURE 3. Cable Set-Top Converter Block Diagram

TL/H/8421-3

Standard television receivers in the U.S. tune to VHF channels 2 through 13 and UHF channels 14 through 83, and initially cable operators used the 12 VHF channels for their program material. With increased sources soon all channels were occupied on some systems creating significant demands on television tuner and I.F. amplifier strips. More space yet was needed and rather than using UHF channel allocations starting at 470 MHz because of cable signal attenuation (typically 0.8 dB/100 ft. at 300 MHz), operators turned to the unused spectrum space between VHF channel 13 and UHF channel 14. Naturally, since standard TV receivers could not tune to these channels, the set-top converter came into being. Each of the new channels could be converted to a low VHF channel to be received on the standard TV. Television manufacturers responded, and with the common introduction of varactor tuners were soon able to offer "cable ready" televisions capable of tuning to all the new cable frequencies. This meant that customer conveniences such as remote control of channel selection also became available. Unfortunately it aggravated a problem already confronting the cable operator. Since standard television receivers couldn't tune to the cable channels, operators had been able to offer premium services on some of these frequencies, paid for by subscribers who rented the appropriate set-top converter box. This didn't prove very secure since one operator's "free" channel was another operator's "pay" channel, and the introduction of cable-ready televisions ensured the eventual demise of such systems.

Scrambling the signal, a technique already being used by over-the-air subscription television, has become common in the cable service. The degree of scrambling* is limited since the scrambled signal spectrum must remain within the channel allocation and anything done to the signal must be subsequently undone without noticeable degradation of the signal.

Generally for television, scrambling means a pulse or sine wave suppression of the signal horizontal blanking pulse interval so that the sync-tips occur between the black and white levels instead of always below black level. The standard television sync separator does not function well with this signal and the I.F./tuner AGC circuits will not work properly, effectively scrambling the displayed picture. Other techniques include random inversion of the video information to provide an even greater degree of security.

The means used to encode such a scrambled signal gives rise to the terms "in band scrambling" and "out of band scrambling". With cable ready television receivers capable of tuning to the scrambled channel, the decoder can be a simple broad-band gain switch (to change the signal R.F. amplitude during horizontal blanking) with a separate receiver tuned to the decoding data carrier frequency, which is

*Other security techniques such as jamming or trapping are used but since jamming is easy to defeat and trapping requires removal or replacement of filters in the cable drop to individual subscribers, scrambling the signal is receiving a lot more attention.

located outside the signal channel. This permits use of the television receiver in a normal way but does require simultaneous switching of the decoder receiver with channel changes.

Also, spectrum space must be reserved for each scrambled channel's data carrier.

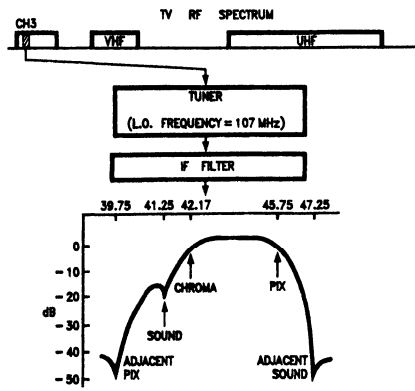
A more popular method of scrambling is "in band scrambling" where the data carrier to decode the signal is included inside the transmitted signal channel, usually within the aural carrier. Any number of channels can be scrambled and now different levels of service can easily be added or deleted without the need to rewire the decoder box. This is achieved by including time multiplexed binary "tags" along with the sync information so that special programs can be identified. Individual subscriber boxes can be similarly addressed and turned on or off by the cable operator. In these types of systems, the LM1823 and LM2889 have obvious applications. The LM1823 is able to provide an excellent baseband signal inside the decoder box, which signal is then remodulated on a low VHF channel carrier by the LM2889 for retransmission to the standard television receiver. Clearly, the highest possible performance is desirable to prevent any noticeable difference between a converted channel, whether scrambled or not, and a regular off-air broadcast channel. (For a complete description of the LM2889 modulator I/C see AN402).

THE RECEIVER FRONT-END

The typical receiver front-end consists of a tuner, I.F. amplifier, I.F. filters and a video/sound intercarrier detector stage. These circuits are designed to provide a number of functions:

- 1) Select (tune) a specific R.F. channel in a band of frequencies.
- 2) Provide rejection to adjacent and other channels in the band.
- 3) Amplify low level R.F./I.F. signals prior to detection of the modulation.
- 4) Avoid overload on high level R.F. signals.
- 5) Trap or attenuate specific frequencies within the channel bandwidth to ensure a proper detected frequency response is obtained.
- 6) Linearly demodulate all desired modulating frequencies on the carrier.
- 7) Produce a noise-free video signal at the detector.
- 8) Provide automatic gain control (AGC) to compensate for changing signal strength at the receiver input.
- 9) Provide automatic frequency control (AFC) to the tuner local oscillator (L.O.) to maintain the carrier intermediate frequency (I.F.).

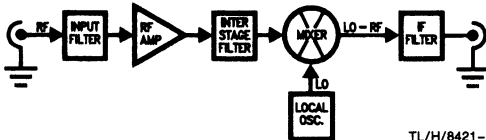
N.B. Items 8) and 9) have previously been provided in part by circuits external to the conventional I.F. amplifier. However, these functions are completely included with the LM1823 leading to overall performance improvements and reduction in external parts count and cost.



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FIGURE 4. R.F. Tuning and I.F. Conversion (Note High Side L.O. Reverses the Relative Position of the Picture Chroma & Sound Carriers. c.f. Figure 1).

Although we are not directly concerned with the tuner design in this application note, it is useful to understand the design goals and constraints on the tuner for at least two reasons. First, since the tuner and I.F. amplifier interact very closely to obtain and maintain a noise-free picture, we need to know something about the tuner in order to provide the correct gain distribution and AGC action. Second, when the two functions are finally placed together, we need to know where to look to solve visible problems that may have become apparent. In some instances, either the tuner or the I.F. amplifier may be at fault, and a good understanding of the system interaction is needed to ensure that the appropriate action is taken.



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FIGURE 5. Typical Single Conversion Tuner

Both single conversion and double conversion techniques are used in cable converter tuners. The single conversion type is similar to the conventional TV receiver tuner and consists essentially of an R.F. stage, mixer stage, and local oscillator. Usually some input filtering is done to help match the cable to the input device and provide some rejection to unwanted signals outside the operating channel. Further rejection to unwanted signals, such as the I.F. frequency radiated back from the I.F. amplifier, is accomplished with inter-stage filtering between the R.F. amplifier and the mixer, and finally an output filter matches the mixer output to the cable feeding the I.F. amplifier. For convenience, we are assuming

the desired output impedance is 75Ω and that the major I.F. amplifier frequency selectivity is determined by a block filter placed between the tuner output and I.F. amplifier input. This is consistent with modern practice using surface acoustic wave filters (SAWF's) and high gain stabilized I/C amplifiers (LM1823). Even so, as noted in more detail later, the LM1823 does provide opportunities for more filtering at the I.F. amplifier output prior to the detector stage.

Dual conversion tuners have been popular for a number of years and use first L.O. frequencies that are above the input R.F. bandwidth, avoiding problems with L.O. leakage back onto the feed cable. The second L.O. and mixer convert the high first I.F. to a Ch 3 or Ch 4 carrier for reception by the TV receiver. The addition of PLL's to control the first L.O. and descrambling networks on the R.F. output have added sufficient complexity to such converters that they are now called "set-top terminals". Also, since the scrambling techniques have become more sophisticated the signal is now frequently converted down to baseband before decoding and re-modulation on Ch 3 or Ch 4 carriers. The high first I.F. has the advantage that image signal rejection is achieved without the switchable filters necessary at the input to the single conversion tuner. However, the absence of these filters does mean that care must be exercised to avoid generation of intermodulation products that "talk back" onto the cable (up conversion of the R.F. signal has been proposed as a way to minimize intermodulation components). Another disadvantage of the dual conversion tuner shown in Figure 6 is that it typically has a very high Noise Figure, often between 14 dB to 16 dB. This is because the signal is applied directly to the first mixer which is a passive, double balanced diode mixer. As discussed in more detail later when we look at SAWF's between the tuner and the I.F. amplifier, a pre-amp in front of the mixer can improve the N.F. to 6 dB to 8 dB, especially in a baseband converter where an AGC voltage is available to help the tuner handle the input signal strength range.

Returning to the single conversion tuner, the major parameters to be considered are as follows:

- 1) Power gain
- 2) Noise Figure
- 3) Good Cross-Modulation rejection
- 4) VSWR
- 5) AGC Range
- 6) Impedance changes with AGC
- 7) Overload capability
- 8) Channel 6 beat rejection
- 9) Curve tilt (tracking)
- 10) L.O. drift and radiation

For an I.F. amplifier design, items 1), 2), 7), and 8) are the most significant, but if the tuner designer has overlooked the others we may see some problems when the tuner and I.F. amplifier are hooked together.

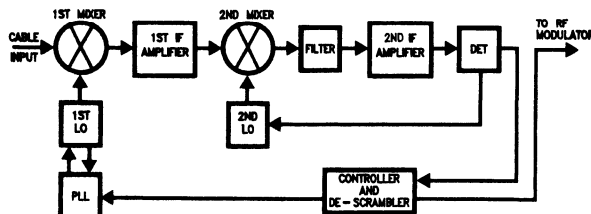


FIGURE 6. Dual Conversion Tuner

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Crossmodulation describes the condition wherein the modulation information on an adjacent channel (usually) is transferred on to the desired carrier. A typical specification is the undesired carrier level with 30% modulation needed to cause 1% modulation of the desired carrier level.

Crossmodulation is particularly likely to occur in cable systems and is usually observed as sync bars drifting through the picture. In particularly severe cases the interfering picture can actually be seen. High signal levels at the input of the mixer are a frequent cause of crossmodulation, particularly when high gain R.F. stages are used to obtain a low tuner noise figure (N.F.). But when AGC is applied the crossmodulation source often shifts to the R.F. device.

When overload occurs, (measured as the total harmonic distortion of a specified modulation frequency), the peaks of the R.F. carrier waveform become compressed and this will show up at the video detector as a smaller sync pulse amplitude (sync tip to black level). Since the AGC system operates on the sync tip level the effective result is that the black level appears to go blacker than black—i.e. some near black information will be lost and the picture will appear to have too much contrast. Alternatively if the subsequent receiver circuits have black level restoration the screen brightness increases and picture tube blooming on peak whites may occur. As overload increases there is a strong chance that vertical sync will be lost. Generally the tuner mixer device is the first stage to overload, followed by the R.F. stage. While overload is caused by very strong signal strengths and therefore may appear to be of limited concern it can also occur at weak to intermediate signal strengths because of incorrect AGC threshold settings and this will be discussed in detail later.

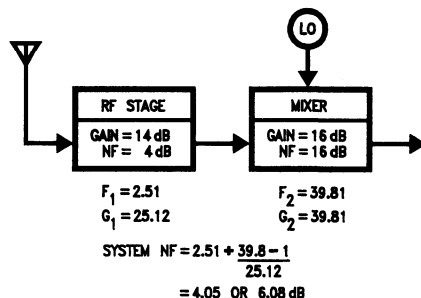
Channel 6 beat is a phenomenon related to mixer overload and occurs because of the choice in the U.S. of 45.75 MHz as the intermediate frequency. On channel 6, mixing of the sound and pix carriers produces a signal at 171 MHz which is then mixed with the channel 6 L.O. frequency to give 42 MHz. The I.F. sound and pix carriers can also mix with the channel 6 L.O. to produce 42 MHz. Since 42 MHz is only 170.455 kHz from the I.F. chroma subcarrier of 42.17 MHz, after detection wavy lines will appear in colored areas of the picture. Turning down the receiver color level (saturation) control will eliminate the 170 kHz pattern and identify the problem as Channel 6 beat.

Curve tilt or tracking refers to the ability of the tuner filters to track the L.O. frequency as the channel selection is changed. Problems in this area are easily identified at the video detector output (sometimes referred to as the 2nd detector) since the effect is to cause changes in the relative amplitudes of the pix, sound and chroma carriers compared to that expected from the I.F. filter response. When the detector VCO and AFT circuits of the LM1823 are aligned to 45.75 MHz, the chroma burst located on the back porch (or breezeway) portion of the horizontal blanking period in the video signal will normally be -6 dB compared to the sync pulse amplitude. If mistracking is causing a loss of high frequencies on certain channels, the burst amplitude will be lower on these channels and the picture (in severe cases) will have watery and noisy colored areas with smeared off picture detail. When the loss occurs down at the pix carrier

frequency, the burst amplitude is increased and the picture will become harsh with excessive overshoots.

Similar problems can occur on any specific channel simply due to mis-tuning or L.O. drift. In particular, as the L.O. frequency drifts high and the chroma subcarrier amplitude increases, the sound carrier also increases and chroma/sound beats will appear in the picture. In the U.S. the chroma/sound carrier beat is at 920 kHz (4.5 MHz—3.58 MHz) and appears as a herringbone pattern while the audio modulates the sound carrier. This 920 kHz beat can also be caused by detector non-linearities, and after the video detector by the detected 4.5 MHz sound intercarrier mixing with the chroma subcarrier in subsequent receiver stages. If turning down the color level control removes the 920 kHz beat then a better 4.5 MHz trap is needed at the video detector output.

These preceding comments are not meant to imply that the tuner is the root cause of all the nasty phenomena that can be observed in the picture display. Overload, Channel 6 beat and video noise are very dependent of the tuner/I.F./AGC interaction. To understand why this is the case, we need to look at the demands that the input signal field strength puts on the system.



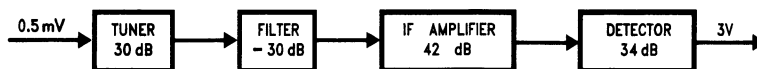
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FIGURE 7. Typical Tuner Gain and Noise Figure

INPUT SIGNAL LEVELS

The smallest input signal is, of course, no signal or simply the noise level generated at the cable drop. To this noise level will be added the input noise of the tuner itself, giving rise to an equivalent noise input defined by the tuner noise figure (N.F.) While a specific design will have to take into account the actual operating parameters of the tuners available, we will assume a typical tuner configuration with an R.F. stage providing 14 dB gain and having a 4 dB N.F., followed by a mixer stage with 16 dB conversion gain and a 16 dB N.F. The N.F. of this combination is 6 dB, a fairly typical number, which will have the effect of increasing the actual input noise by a factor of 2. If our noise source is the cable impedance with a real part of 75Ω , at an ambient temperature of 290K, then the equivalent input noise is 2.2 μVrms (the noise contribution of any matching network or cable termination is ignored as this is included in the tuner N.F.).

Cable signal levels run from -6 dBmV to $+15$ dBmV with a typical system goal of maintaining a C/N ratio of at least



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FIGURE 8. System Gain Distribution

43 dB at the cable drop to the subscriber. If a 0.5 mVrms signal is to produce the rated detector output of 3V (o-p)* for the LM1823 then we need a total system gain of at least 75 dB. Usually the SAWF connected between the tuner output and the I.F. input will have an insertion loss of 20 dB to 30 dB so that with the 30 dB tuner gain, the I.F. amplifier/detector is required to provide the remaining 76 dB. If the tuner is simply a diode mixer with a 6–8 dB insertion loss, the gain requirement increases to 114 dB.

* (o-p) means the detected zero carrier voltage level to the detected sync tip voltage level. The actual peak white signal to sync tip excursion at the detector will be 87.5% of this—2.63V (p-p). In the absence of a carrier, thermal noise will be present with amplitude peaks on both sides of the detected zero carrier voltage.

Fortunately the LM1823 has a high conversion gain detector (34 dB) and the I.F. amplifier gain can be set to well over 75 dB at 45.75 MHz (but we will see that some gain prior to the I.F. amplifier filter will be necessary if a good system N.F. is desired). Substantially more gain than necessary should be avoided however, even though there is plenty of AGC range in the I.F. amplifier (from 48 dB to 60 dB depending on external components). While at least 22 dB AGC capability is needed to accommodate the expected input signal strength range, if excessive system gain is used, forcing the I.F. amplifier into early gain reduction, the I.F. amplifier N.F. will begin to increase. With a diode mixer front end, the I.F. amplifier N.F. may contribute directly to the system N.F. and prevent noise-free pictures from being obtained. If a pre-amp or tuner is part of the AGC loop, gain reduction should be limited to the I.F. amplifier as much as possible, transferring gain reduction to the tuner only when the signal strength is high enough to cause distortion or cross modulation problems. The tuner gain will prevent the prior increase in I.F. amplifier N.F. from impacting the system noise performance, but excess system gain causing premature tuner gain reduction will increase the tuner N.F. and hence the system N.F.

Of great interest to us is the R.F.C/N ratio required for the detected output to be considered noise free. Actual television video S/N ratios are a little complicated by the fact that the displayed video signal does not occupy the full R.F. carrier envelope. 25% of the carrier is reserved for the synchronizing pulses and 12 1/2% is retained even under conditions of peak white modulation, for the benefit of intercarrier sound detectors. A common definition of the video S/N ratio is the ratio measured in decibels of the peak video signal amplitude to the r.m.s. noise voltage amplitude. In this context peak video refers to the voltage excursion between black and white levels (from 75% peak carrier to 12 1/2% peak carrier). With this definition in mind, it is generally accepted that the subjective effect of imperceptible noise occurs at an S/N ratio of 43 dB. Noise will become perceptible (for most viewers) at an S/N ratio around 38 dB; is clearly visible but not necessarily disturbing at 34 dB and becomes objectionable at 28 dB to 30 dB. Alternatively if we measure the signal amplitude as an r.m.s. sine wave with the same peak to peak amplitude as the R.F. carrier during the sync

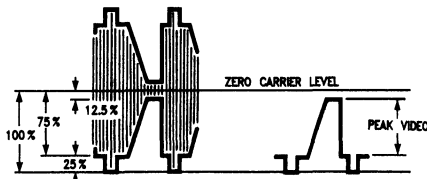


FIGURE 9. Television R.F. Modulation Envelope

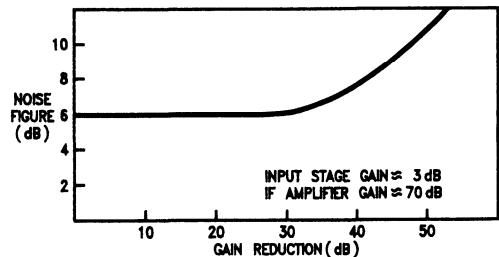
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pulse period, our signal is free of noise for a 47 dB C/N ratio.

If the input signal were completely noise-free (i.e. no excess noise from head-end amplifiers etc.) then the detected C/N ratio is determined by the equivalent input noise level of the tuner—2.2 uVrms for a 6 dB N.F. With a minimum signal level of 0.5 mVrms the detected C/N ratio will be 47 dB for the converter alone. When the actual signal has noise, for a cable C/N ratio of 43 dB the noise detected at the converter output is now

$$e_n = 10^{-6} \sqrt{(2.2)^2 + (3.5)^2} = 4.13 \mu\text{V}$$

This gives a detected C/N ratio of 41.6 dB, a loss of 1.3 dB compared to the original signal. For most viewers this is the just perceptible level for video noise. On the other hand, if a 14 dB N.F. converter is used, the detected C/N is 32.7 dB which is considered objectionable. A 0 dBmV signal would produce 38.7 dB C/N ratio which would be acceptable. Obviously a low N.F. is important, and any increases in N.F. should be carefully controlled to get the best picture quality possible. Figure 10 shows the change in N.F. for the LM1823 I.F. amplifier. For over 30 dB gain reduction, the N.F. is unchanged and increases by only 4 dB for the next 20 dB of gain reduction.

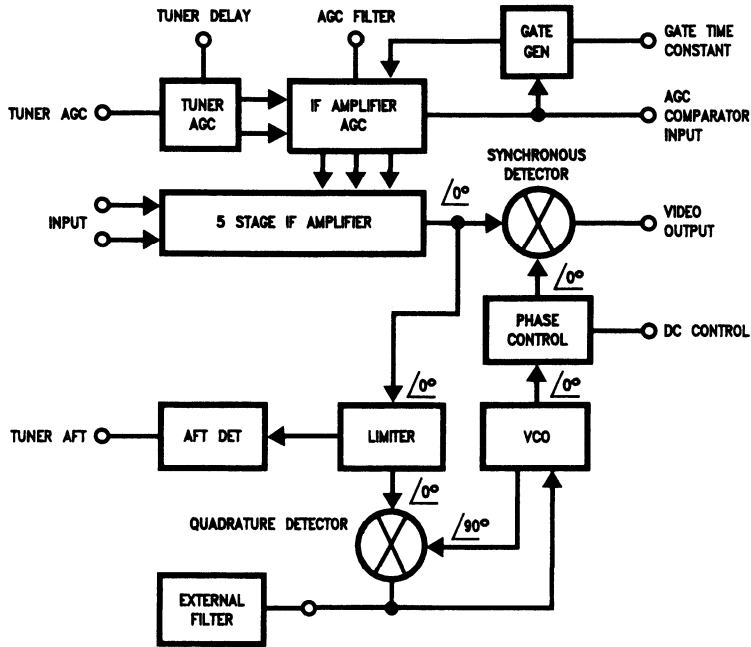


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FIGURE 10. Increase in I.F. Amplifier N.F. with Gain Reduction

LM1823-GENERAL CIRCUIT DESCRIPTION

The basic arrangement of the LM1823 is shown in Figure 11. A five stage I.F. amplifier provides gain with a low impedance input stage to ensure adequate suppression of triple transit echo in SAW filters, and AGC on the three inter-stages. The output stage buffers the I.F. signal which is split off into two paths. A linear path takes the modulated signal to a true synchronous detector while a high gain limiter amplifier passes the I.F. carrier waveform to a second phase detector which is part of the PLL for the VCO. The PLL has an externally adjustable filter and locks the oscillator in quadrature with the incoming I.F. carrier. An in-phase component of the oscillator also drives the linear path detector to recover the signal amplitude modulation. An external DC control allows fine adjustment of the detection phase in order to optimize the detector linearity. The output from the detector is coupled back into the AGC comparator input, and is internally gated during the sync pulse period for good noise immunity and a fast response. Two AGC voltages are available; an early AGC for the I.F. amplifiers and a late, or delayed AGC for the tuner. The take-over point between the I.F. AGC and the tuner AGC is set by an external potentiometer. Also included is an AFT output for fine control of the tuner L.O. All these functions are contained in a 28-pin DIP with a pin-out designed to facilitate stable p.c.b. layouts—even with the high system gain of the LM1823 at frequencies up to 70 MHz.



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FIGURE 11. Block Diagram of the LM1823

I.F. Amplifier Stages:

The LM1823 I.F. amplifier is composed of five separate stages designed to provide high gain primarily in the frequency range of 35 MHz to 60 MHz, and gain control over a 60 dB range without overload of any stage and without introducing excess noise into the signal.

To achieve this, AGC is applied to the second through fourth stages by a control voltage that is either internally generated from the video detector output or from an externally applied bias voltage at Pin 13. AGC action starts when the voltage at Pin 13 reaches approximately 4 VDC and over 50 dB of gain reduction is obtained by the time Pin 13 voltage reaches 6.5 VDC. For a typical application, the I.F. noise figure is around 6 dB for the first 30 dB of gain reduction, and then begins to increase to above 10 dB by the time the amplifier is gain reduced over 50 dB (see Figure 10).

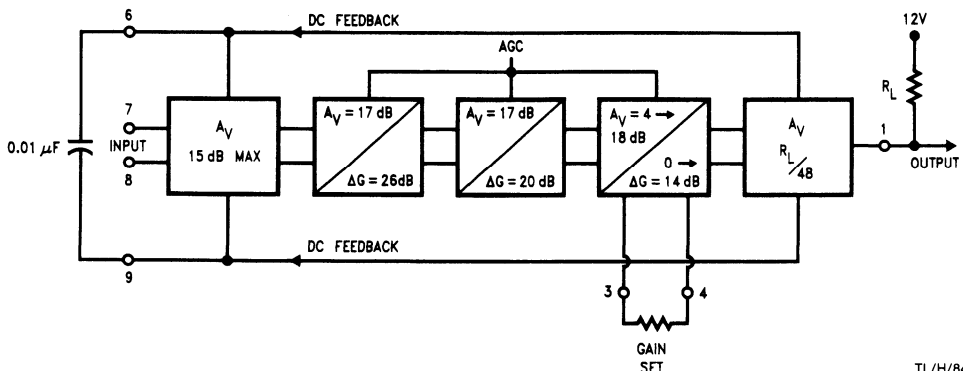
As mentioned earlier, the total system gain desired from the I.F. amplifier input to the video detector output needs to be

selected for a specific set of tuner parameters and I.F. filter losses. Excess gain simply means premature AGC action with possible loss of optimum video S/N ratios. To see how and where the LM1823 gain can be adjusted, we will look at each gain stage in turn.

Input Stage:

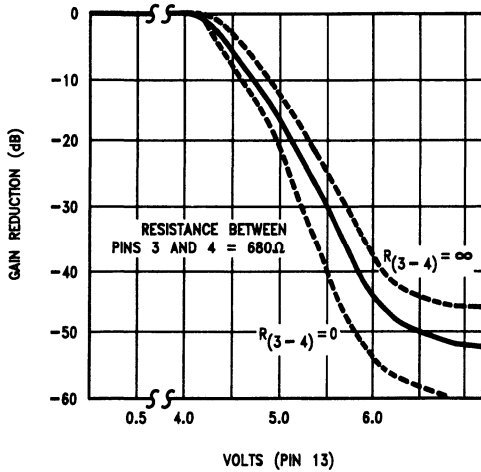
The input stage is a common-base differential amplifier designed to give good rejection of unwanted I.F. output and detector VCO signals that may be radiated back to the input. The low input impedance of 60Ω ensures that SAW filters are terminated sufficiently to keep the TTE better than 40 dB below the signal level, even with low impedance SAWF's. Because it is a common base stage, the input stage gain is determined by the source impedance presented to the input. An approximate expression for the gain is given by Equation (1)

$$A_v = 531 / (Z_s + 60) \tag{1}$$



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FIGURE 12. Gain Distribution in the I.F. Amplifier



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FIGURE 13. I.F. Amplifier Gain Reduction Characteristic

As an example, if we use a high impedance SAW filter such as the Murata SAF45 MC series with an output impedance that can be modelled as a 2.8 k Ω resistor in parallel with 8 pF capacitance, our input Z_s is 345 Ω (including 2 pF input stray capacitance) at 45.75 MHz. From (1), the input stage gain is 2.4 dB. If a filter is used that matches to the input stage with 60 Ω , then the gain can be as much as 13 dB.

A balanced input is extremely important since the input leads Pins 6–9 are the most sensitive parts in the system to unwanted I.F. coupling. For example, if the I.F. output couples into these pins it can cause changes in the frequency response and can easily promote oscillation. A spectrum analyzer is invaluable for helping determine the system susceptibility to this phenomenon. With the input terminated by the I.F. filter (or an equivalent resistor), the I.F. amplifier output noise spectrum will show if oscillation is likely to occur.

Another signal that can appear at the input is the detector local oscillator waveform. Unlike quasi-synchronous detectors, the LM1823 has a constant (and relatively high) oscillator signal for good linear detection, even with low input signal levels. It is the balance between the input pins to the VCO radiation pick-up that will determine whether the p.c.b. layout is good enough. VCO pick-up can cause AFC skewing and asymmetrical oscillator pull-in, but probably the most serious effect is failure of the oscillator to acquire lock at weak signal levels. This is caused by the fact that the PLL

phase detector sees two input frequencies—the desired I.F. and the undesired L.O. frequency. As a result the L.O. “chases itself” and is driven outside the loop acquisition range.

Again the spectrum analyzer is a useful tool for measuring the level of VCO pick-up and the degree of improvement that any circuit modification or component relocation makes. A good layout will have symmetrical input leads placed as close together as possible, shielded input coils (where used) and external components mounted as close to the I/C as possible. The DC feedback decoupling capacitor connected between Pins 6 & 9 should be right against the pins. The pcb layout shown later, even though it uses an I/C socket, is able to keep the equivalent VCO input level to under 2 μ Vrms. To put this number in perspective, it is –97 dB compared to the original VCO level. For the measurements, the spectrum analyzer should be connected through a FET probe at the I.F. output, which is disconnected from the detector stage. The VCO control pin is grounded, the detector input is de-coupled with a 0.01 μ F capacitor to ground, and a reference signal CW of the order of 100 μ Vrms is applied at the filter input.

Second and Third Stages

These are easy to handle since they are completely self contained within the LM1823. The maximum gain is fixed at 17 dB each with 26 dB and 20 dB of gain reduction capability respectively.

Fourth Stage

Unlike the preceding stages, the emitters of the fourth differential amplifier are available at Pins 3 & 4. An internal resistance of 1360 Ω between these pins sets the minimum stage gain at 4 dB, and under these conditions (Pins 3 & 4 open) the stage does not provide significant gain reduction with AGC action. However, when an external resistor is connected between the emitters, the gain increases. For Pins 3 & 4 shorted together the gain is as much as 18 dB and the stage can provide up to 14 dB gain reduction with AGC action. Because of the way in which the total I.F. amplifier gain reduction is shared between the stages, the effective gain increase obtained by a resistor between Pins 3 & 4 occurs only for signals below the AGC threshold. After 20 dB of system gain reduction the fourth stage is fixed at 4 dB.

Fifth Stage and I.F. Amplifier Output

The fifth and final I.F. amplifier stage has a single-ended output. There is no internal connection to the detector stage, permitting convenient isolation of the IF amplifier and detector functions. Pin 1 is also a point at which any additional signal filtering may be applied. A resistive load con-

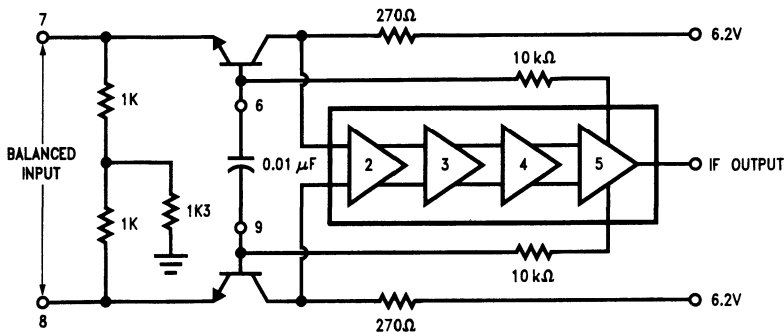


FIGURE 14. Low Impedance Common Base Input Stage

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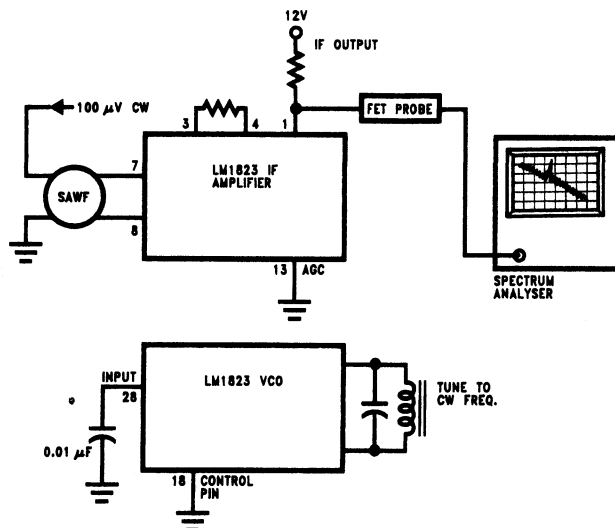
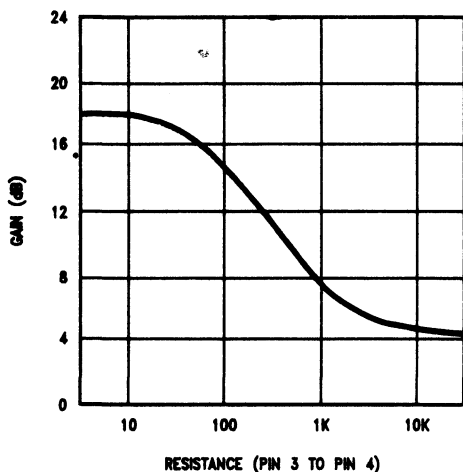


FIGURE 15. Checking the pcb for Excess VCO Pick-up

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RESISTANCE (PIN 3 TO PIN 4)

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FIGURE 16. Fourth I.F. Amplifier Stage Gain with External Resistor

connected to the 12V power supply can be used, but the maximum value is limited in practice to less than 500Ω at intermediate frequencies because of stray p.c.b. capacitance and the loading of the detector stage input impedance of 3 kΩ. The stage gain for a total load impedance of Z is given by Equation (2)

$$AV = 1Z1/48 \quad (2)$$

The last part of the I.F. amplifier concerns the power supply input at Pin 5. This is a shunt regulated input with a nominal value of 6.3V and the I.F. amplifier current is delivered through a dropping resistor from the 12V rail supplying the remainder of the I/C. The 0.01 μF ceramic r.f. decoupling capacitor at Pin 5 should be grounded through very short

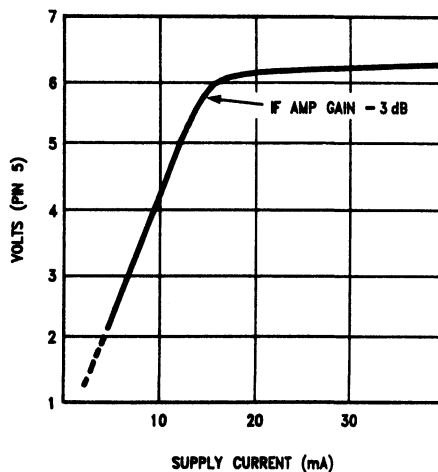


FIGURE 17. I.F. Amplifier Voltage Regulator Current Requirement

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leads—preferably on the copper side of the p.c.b. A nominal current level into Pin 5 is 32 mA, set by a 180Ω resistor. This current should not exceed 60 mA and the minimum current is about 20 mA, below which the I.F. amplifier will start to lose gain as Pin 5 voltage drops below the regulated level.

SELECTING THE I.F. GAIN

Clearly the LM1823, with all the gain provided by five I.F. amplifier stages and with 34 dB detector conversion gain, has a more than adequate gain margin to provide signal sensitivity and compensate for interstage filter losses. To show how this gain may be distributed we can look at a first cut design example.

If we continue with the 30 dB gain tuner with a 6 dB N.F., using the tuner 75Ω output to mismaternate the SAWF input will produce a very high insertion loss for the filter. This can easily be over 30 dB but before using the LM1823 gain capability to compensate for this loss, we must look at another aspect of filter insertion loss—the N.F. goes up! Previously we assumed that the tuner N.F. will dominate the system N.F.—and with a tuner amplifier N.F. of 6 dB and 30 dB gain this is indeed true. But when the I.F. amplifier and SAWF are combined the N.F. for the combination exceeds 30 dB. This degrades the system N.F. to 7 dB* and after 50 dB of I.F. amplifier gain reduction the N.F. will be over 8 dB. Frequently this will be alright but it is instructive to consider improving the SAWF N.F. by matching the tuner output impedance to the filter or using an impedance matching pre-amp. For example, the 10 dB gain pre-amp shown in Figure 18 has a 4 dB N.F. and reduces the filter loss to less than 20 dB. After 50 dB I.F. amplifier gain reduction, the combined N.F. is only 27 dB—for a worst case system N.F. of 6.6 dB. In a dual conversion system with a diode mixer (and already high N.F.), some gain *must* be provided prior to the SAWF.

$$*NF_{\text{system}} = NF_{\text{tuner}} + \frac{NF_{\text{IF}}}{(\text{Tuner Gain})}$$

Leaving a 10 dB gain margin over that required to raise a -6 dBmV signal to the rated detector output, the total gain requirement of the I.F. amplifier is

$$75.6 \text{ dB} - 30 \text{ dB} + 30 \text{ dB} - 34 \text{ dB} + 10 \text{ dB} = 51.6 \text{ dB}$$

(0.5 mV → 3V) (tuner) (SAWF) (detector) (gain margin)

(With a 10 dB gain impedance matching amplifier between the tuner and the SAWF, the gain requirement falls by 20 dB to 31.6 dB.) To avoid overload in the high gain tuner, we probably have to start gain reducing the tuner when the input signal reaches +10 dBmV (but certainly not before 0 dBmV in order to preserve the tuner NF) so that the I.F. AGC range requirement is approximately 26 dB. This amount of AGC range can be obtained without a resistor connected between Pins 4 & 5 putting the fourth stage gain

inserted between the I.F. amplifier output and the detector input when a pre-amp is used.

LM1823 VIDEO DETECTOR

The second major function of the LM1823 is the video detector stage, including the AFT/AFC detector and AGC detector/amplifier.

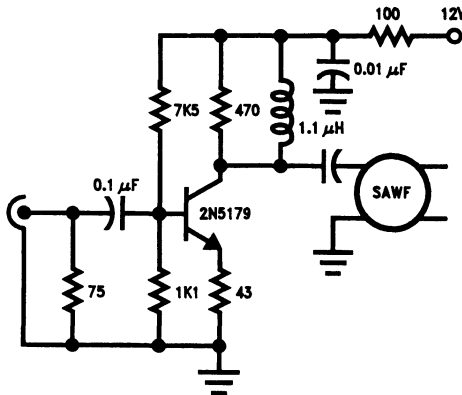
The video detector stage of the LM1823 has a fixed conversion gain of 34 dB—giving a 60 Vrms input level for a 3V (0-p) detected output. This input level is required for AGC action to commence and is well below the input level that can cause intermodulation or catastrophic overload.

Synchronous detection of an amplitude modulated carrier involves a source of constant amplitude CW with the same frequency as the signal carrier, and two phase detectors. One detector is operated in quadrature—i.e. the CW phase and the signal carrier phase have a 90 degree difference at the inputs to the phase detector. This detector operates solely to keep the CW source phase-locked to the signal carrier. The second phase detector has synchronous or in-phase inputs so that the detector output responds to the amplitude difference between the inputs and therefore tracks the signal amplitude modulation.

The benefits of synchronous detection over envelope detection are well known, and most modern receivers incorporate a type of detector known as a quasi-synchronous detector, which is a signal amplitude detector. The I.F. signal is amplified and stripped of modulation in order to be used as the detector CW. The disadvantages of this type of detector are the loss of linearity at very low signal inputs (corresponding to peak video modulation) and a fundamental compromise in the bandwidth of the limiter stage used to strip the modulation. To maintain ease of tuning and a relative immunity from center frequency drift caused by temperature changes and aging, the limiter bandwidth is sufficiently wide that the resulting CW is phase modulated by the information on the original I.F. carrier. Since this can generate intermodulation products, a high Q is desirable and a trade-off in ease of alignment occurs.

A less obvious problem with this type of detector is the actual static detection phase that is being regenerated. Internal I/C related phase shifts cause the limited carrier waveform applied to the detector to be more or less than 0 degrees phase-shifted with respect to the signal carrier phase. A loss in detector efficiency results, but if the limiter tuning is adjusted to compensate for this, the CW phase from the limiter will depend on the drive to the limiter. The detection phase then changes with amplitude modulation of the original I.F. carrier. The effect of this is observed primarily as differential phase in the chroma subcarrier signal and increased levels of sound buzz. Although, as discussed later, the desired phase difference between the detector CW and signal carrier is not necessarily 0 degrees, the limiter tuning cannot be used to correct the amplitude modulation detector phase—the limiter must be center tuned to avoid carrier phase shifts with modulation level.

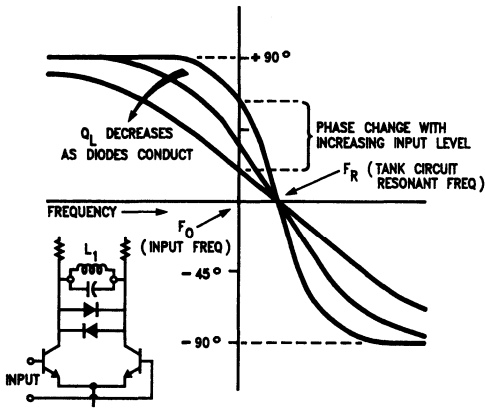
The LM1823 overcomes these problems by providing a true synchronous detector system, which, as the block diagram shows, comprises of an internal VCO and in-phase and quadrature phase detectors. The incoming signal from the



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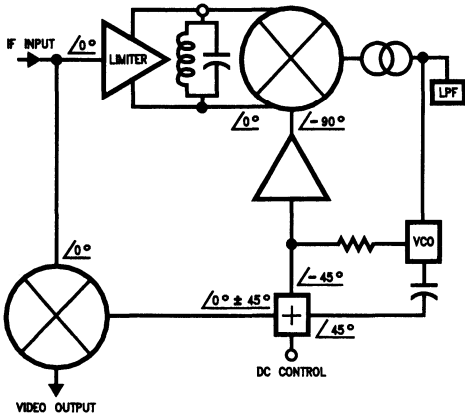
FIGURE 18. Impedance Matching Pre-amplifier

at 4 dB. The SAWF impedance sets the input stage gain at 3 dB for a total of 41 dB to the input of the final stage. A 180Ω resistor at Pin 1 gives the desired last stage gain of 11 dB, or this resistor is reduced to 50Ω and a 10 dB pad is



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FIGURE 19. Limited I.F. Carrier Phase Shifts with Input Amplitude when the Limiter Tank is Mismatched

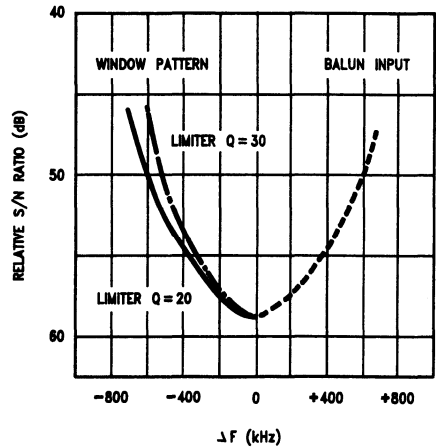


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FIGURE 20. LM1823 Synchronous Detector and DC Controlled Detection Phase

I.F. amplifier is split into two paths. One path is through a high gain limiter stage which strips the amplitude modulation from the CW and applies it to one input of the quadrature phase detector. The other detector input is from the VCO and, once synchronized to the intermediate frequency, if the VCO phase deviates from a 90 degree relationship with the limiter CW phase, a control current is generated by the phase detector and is filtered at Pin 18 to correct the VCO. Even though the limiter stage tuned circuit faces the same compromises of desired narrow bandwidth versus ease and stability of tuning, the filter at Pin 18 can be made to have a very narrow bandwidth. Therefore the VCO can provide a reference signal to the phase detectors with a high degree of spectral purity. The second path for the I.F. signal is directly to the in-phase detector. The VCO output passes through a DC voltage controlled phase shifter before being applied to this detector. The DC phase shifter allows precise adjustment of the synchronized VCO phase for maximum amplitude modulation detection efficiency, and compensates for any internal I/C phase shift variations. At the same time, proper center-tuning of the limiter coil is possible.

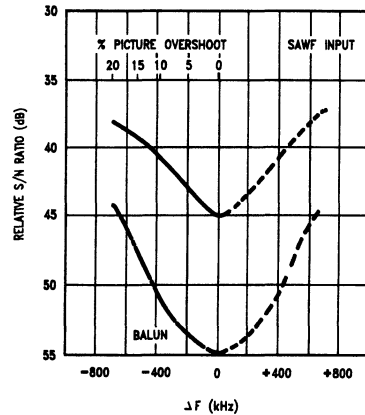
The benefits of center-tuning the limiter are clearly shown by comparing the differential chroma phase of the LM1823



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FIGURE 21. Relative S/N Ratio with Limiter Tuning (No SAWF)

with a conventional quasi-synchronous detector. The LM1823 can consistently produce DP'S of under 1 degree compared with up to 10 degrees for a quasi-synchronous detector. There is also a substantial improvement in the sound carrier S/N ratio. When the limiter is detuned to compensate for internal I/C phase shifts or for detection phase lags to produce video overshoots (for a subjectively crisper picture), the S/N ratio degrades by 5 dB to 7 dB, depending on the video modulating signal.



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FIGURE 22. Effect of Limiter Retuning with SAWF

THE LIMITER

The limiter tuned circuit at Pins 24 and 25 is driven by a differential stage with a 6.6 kΩ internal load impedance. A small signal gain of 50 (with a tuned circuit dynamic resistance of 8 KΩ) ensures that full quadrature detector efficiency is obtained with input levels above 10 mVrms, and internal Schottky diodes limit the maximum amplitude at Pins 24 and 25 to about 500 mV (p-p). Tuning is achieved either for a peak amplitude signal measured with an F.E.T. probe (low

capacitance) at Pin 24 or Pin 25 with a 10 mVrms CW input, or by monitoring the video detector and adjusting for minimum differential chroma subcarrier phase. The latter adjustment will require a signal source modulated with a chroma/video ramp or stair-step pattern including a 20 IRE level chroma subcarrier, but does have the advantage that the adjustment can be made at strong signal levels, and does not require dis-connection of the tuner.

AFT/AFC CIRCUIT

The AFT phase detector is a doubly-balanced phase detector with the switching signal provided internally from the limiter stage described previously. The quadrature signal input is obtained by light external capacitive coupling from the limiter tuned circuit to the AFT tuned circuit at Pins 23 and 26. Parallel p.c.b. tracks to the limiter and AFT coils will usually provide sufficient coupling and the 1 pF capacitors on the LM1823 test circuit (see LM1823 data sheet) are shown only to illustrate the level of coupling involved. Since the AFT tuned circuit is driving an amplifier with a differential input resistance of 20 kΩ, it is able to operate close to the unloaded Q of the inductor.

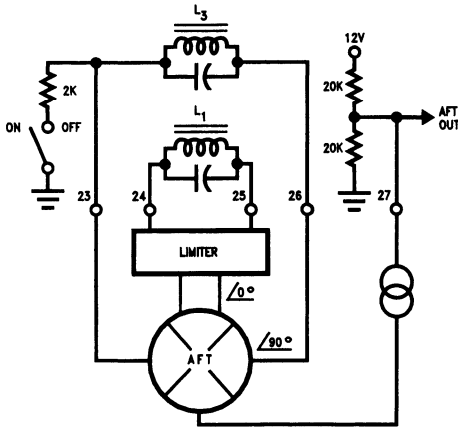


FIGURE 23. AFT Circuit with pcb Coupling Between the Limiter & AFT Tuned Circuits

The AFT output Pin 27 is driven from a current source so that the output voltage at the proper center frequency is set by an external resistive divider network. The parallel resistance of this divider will determine the voltage swing obtained for a given frequency deviation and in combination with the AFT tuned circuit Q, provides a means to adjust the AFT output slope.

Once outside the desired tuning range the AFT output voltage should stay either close to ground (I.F. frequency high) or close to the positive supply voltage (I.F. frequency low). If the voltage moves back towards the center voltage as the signal moves further away from the desired tuning range, then more coupling from the limiter tank may be needed. Grounding Pin 26 through a 2 kΩ resistor will defeat the AFT circuit for receiver fine-tuning purposes. The 2 kΩ provides isolation of the AFT switch & associated cable from the tuned circuit which has a relatively low dynamic resistance of 1.8 kΩ. Resistor values larger than 2 kΩ may prevent the circuit from being defeated, but either Pin 23 or Pin 26 can be grounded directly without damaging the I/C.

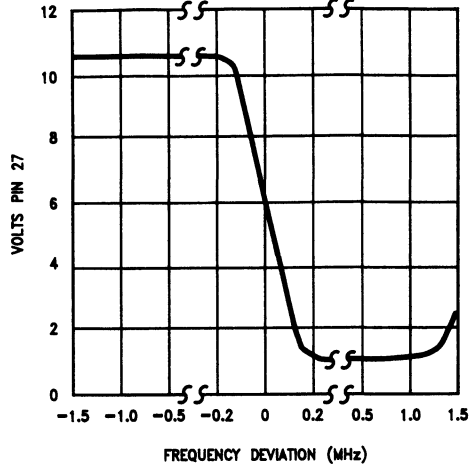


FIGURE 24. AFT Circuit Output Voltage Characteristic (RLOAD at Pin 27 = 10 kΩ)

THE PHASE LOCKED LOOP (PLL)

For true synchronous operation the LM1823 has an internal VCO operating at the video intermediate frequency of 45.75 MHz.

A parallel tuned circuit between Pins 19 and 20 will set the oscillator free-running center frequency and the tuned circuit dynamic resistance is loaded by an internal 1.5 kΩ resistor. Since the oscillator frequency must be controlled, a basic tradeoff exists between oscillator stability, control sensitivity and control range. To obtain a control range of over 2 MHz, the working Q of the tuned circuit should be around 15. Increasing the Q by raising the capacitive arm of the tuned circuit will improve the oscillator stability. This reduces the change in free-running frequency as a result of temperature effects etc. The control sensitivity will decrease correspondingly and there will be a reduction in the control range. The control range in the application circuit has been chosen to cover the expected deviations in the I.F. carrier that are allowed by AFT circuits. With a coil unloaded Qu of

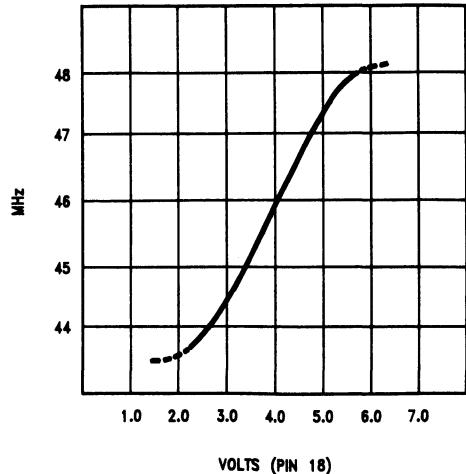


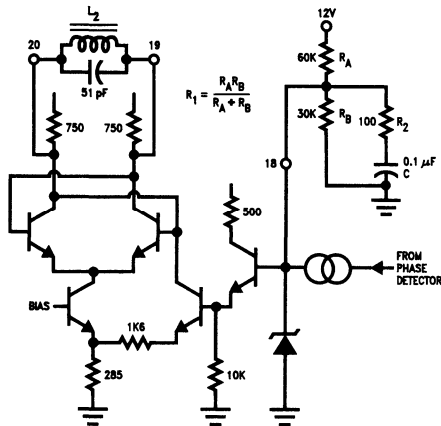
FIGURE 25. VCO Control Sensitivity Characteristic

55, and a working Q of 15, the inductance should be 0.24 uH, which tunes with 51 pF at 45.75 MHz.

The V.C.O. frequency is adjusted by injecting a 60 mVrms CW at Pin 28. If the VCO tuning (L_3) is a long way from being correct, the detector output Pin 16 will show an AC signal of about 4V (p-p) centered around 7.5 VDC. As the oscillator is tuned toward the correct frequency the AC beat note will decrease and abruptly disappear as the oscillator locks to the carrier frequency. Final adjustment of the VCO is done by tuning L_3 until the voltage at the phase detector filter Pin 18 is 4 VDC.

Oscillator control is accomplished by internally phase shifting the currents in a direct cross-coupled differential stage in response to the control voltage developed at Pin 18. Direct cross-coupling of the bases and collectors of this differential stage means that the transistors are operating in a soft-saturated mode, enabling a constant output amplitude to be obtained of about 500 mV (p-p). This output amplitude does not change with coil tuning or over the frequency control range of the oscillator. With the specified tuning components at Pins 19 and 20, the VCO sensitivity is 1.5 MHz/volt. Other general characteristics of the VCO are a negative temperature coefficient of 150 ppm/degree C, and a tendency for the oscillator control sensitivity to decrease with decreasing frequency of operation (below 10 MHz).

The VCO tuning components are mounted across the I/C package from the I.F. amplifier input. This minimizes inductive coupling and yields approximately 105 dB isolation for the I/C alone. Leads and components connected to the I.F. amplifier input will reduce the VCO isolation (as will higher operating frequencies).



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FIGURE 26. LM1823 VCO Circuit

The quadrature phase detector output is a push-pull current source so that the control voltage at Pin 18 is determined by the parallel resistance of the external divider network, which also sets the quiescent control voltage in the absence of an I.F. signal. This divider voltage should be centered at 4 VDC since the lower voltage swing for controlling the oscillator frequency is 2 VDC, and an internal clamp prevents Pin 18 increasing above 5.6 VDC. By using a 20 kΩ parallel resistance at Pin 18, the phase detector current of 7.5 uA/degree gives a phase detector sensitivity (μ) of 0.15 volts/degree. This parallel resistance is equivalent to R1 in the conventional filter for a 2nd order PLL. The oscillator and phase detector sensitivities given above yield a DC loop gain of 12.9 MHz/radian. For the data sheet value of 100Ω for R2,

and a filter capacitor of 0.1 uF, the loop damping factor (K) is 1.01 and the natural resonant frequency (ω_n) is 32 kHz. From this we can calculate that the loop -3 dB bandwidth is 73 kHz which is substantially less than would be practicable with a quasi-synchronous detection system, and this brings the desired benefits of low luma/sound/chroma crosstalk and freedom from quadrature distortion produced by the I.F. filter slope characteristic in the vicinity of the picture carrier frequency. Nevertheless, some signal conditions may cause wider PLL bandwidths to be used. A probable problem is incidental carrier phase modulation (ICPM).

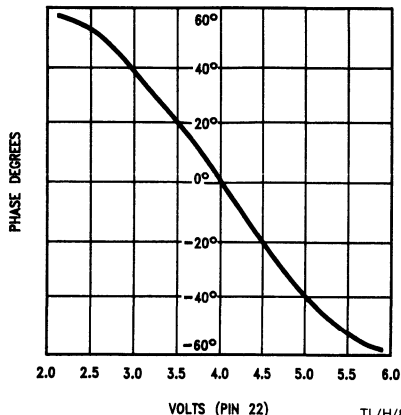


FIGURE 27. DC Controlled Phase Shifter Characteristic

This describes the shift in carrier phase as the modulation depth changes, and is particularly likely to happen where prior processing of the original carrier waveform has occurred—in distribution or conversion amplifiers employed in MATV and cable systems for example. It is also present to an extent in broadcast transmitters and if the PLL loop bandwidth is too narrow for the VCO to track this phase shift, then the ICPM is transferred to the signal modulation. This can be observed as a tint shift in color bars or a smear

PHASE LOCKED LOOP PARAMETERS		
$R_1 = R_A \parallel R_B$	VCO SENSITIVITY (β) = 1.5 MHz/VOLT PHASE DETECTOR SENSITIVITY (μ) = 0.15V/DEGREE	
DC LOOP GAIN ($\mu\beta$) = $\omega_n^2 C / 2\pi$ LOOP NATURAL FREQUENCY (F_n) = $\omega_n / 2\pi$		
$\omega_n = \sqrt{\frac{W_c}{C(R_1 + R_2)}}$		
LOOP DAMPING FACTOR (K) = $\frac{R_2}{2} \sqrt{\frac{C W_c}{R_1}}$		
LOOP -3dB FREQUENCY = $\omega_n / 2\pi \left[2K^2 + 1 + \sqrt{(2K^2 + 1)^2 + 1} \right]^{1/2} \approx \frac{\omega_n 2K}{\pi}$ (K > 2)		
$W_c = 81 \times 10^6$ RADS/SEC $\omega_n = 2 \times 10^5$ RADS/SEC	$R_2 = 100\Omega$	$R_2 = 680\Omega$
	$K = 1.01$	$K = 69$
	$F_{3dB} = 56$ KHz	$F_{3dB} = 440$ KHz

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in the leading edge of a color bar as the VCO belatedly attempts to track the phase change. For these types of signals it is desirable to increase the loop bandwidth to about 500 kHz—changing R2 to 680Ω is an easy fix. The loop damping factor is kept greater than 1 to avoid ringing on the phase transients. Larger loop bandwidths will increase the possibility of luma/sound/chroma crosstalk.

Once the VCO is locked in phase to the I.F. signal, the DC phase shifter Pin 22 is normally around 4 VDC for peak detector efficiency. Usually some extra phase lag will be introduced since a subjectively crisper picture is obtained if picture transients have an overshoot. Between 12% and 20% overshoot without ringing is desirable, corresponding to a 400 mV to 800 mV shift in Pin 22 voltage.

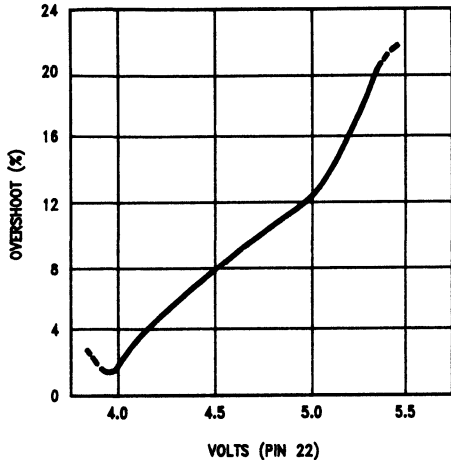


FIGURE 28. Signal Overshoot Produced by Carrier Detection Phase Shift

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VIDEO DETECTOR POST AMPLIFIER

The response of the video amplifier is rolled off above 9 MHz to minimize the amount of the VCO waveform and its harmonics appearing in the output at Pin 16. Typical oscillator products are 40 dB below the desired signal level.

Zener diodes are used in the video amplifiers for level shifting so that the use of PNP transistors is avoided and the detector linearity is preserved. Excellent differential gain characteristics are obtained—typically less than 3%. Pin 16 is a Darlington NPN emitter follower output. With no detector CW input signal, Pin 16 is at 7.6 VDC, representing zero carrier level which is slightly higher than peak white (by 12½%). As the CW input increases, Pin 16 voltage decreases towards black level with the sync pulses producing the most negative detector level.

The level reached by the sync tips is determined by the AGC loop threshold and if the internal AGC comparator is used (Pin 16 is directly connected to Pin 17), the sync tips will be clamped at 4 VDC. This produces a nominal detector output of 3.2V (p-p) but this is subject to variations in the Pin 16 detected zero carrier level. The resistive network shown connected between Pin 16 and Pin 17 in Figure 30 can be used to change the zero carrier level at Pin 17 for an adjustable recovered video level. For best performance the recovered video level should never be less than 1V (p-p) or greater than 4V (p-p). In suppressed sync systems, the recovered video at Pin 16 is routed to the descrambler for restoration of the sync amplitude before it is applied to Pin 17. Obviously the signal DC content must be preserved through the descrambler if proper AGC action is to be maintained.

AGC Self Gating Comparator (LM1823)

The AGC comparator input has a low pass filter to protect the AGC loop from noise interference. Conventional detector systems often use noise gates to prevent the AGC system “backing off” on noise peaks that occur below the sync tip level. It is difficult to set the noise gate threshold close enough to the sync tip level for it to provide any benefit without risking AGC lock-out. For the LM1823 however, syn-

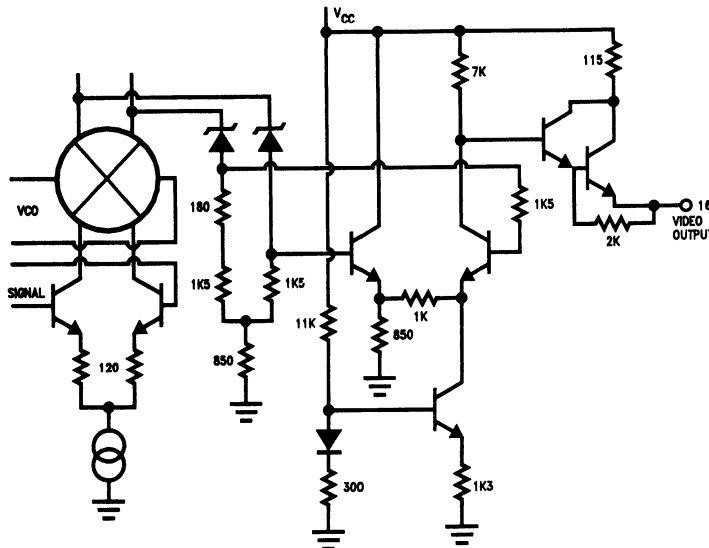


FIGURE 29. LM1823 Detector and Video Amplifier

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A typical slice level for a 3V (o-p) video signal is between 100 mV and 250 mV. Different slice levels can be obtained with other capacitor values (the resistor should be left unchanged). Small capacitors will allow a faster response to a fluctuating sync tip level but also may cause the consequently deeper slice to include video overshoots.

RE AGC DELAY AND OUTPUT AMPLIFIER

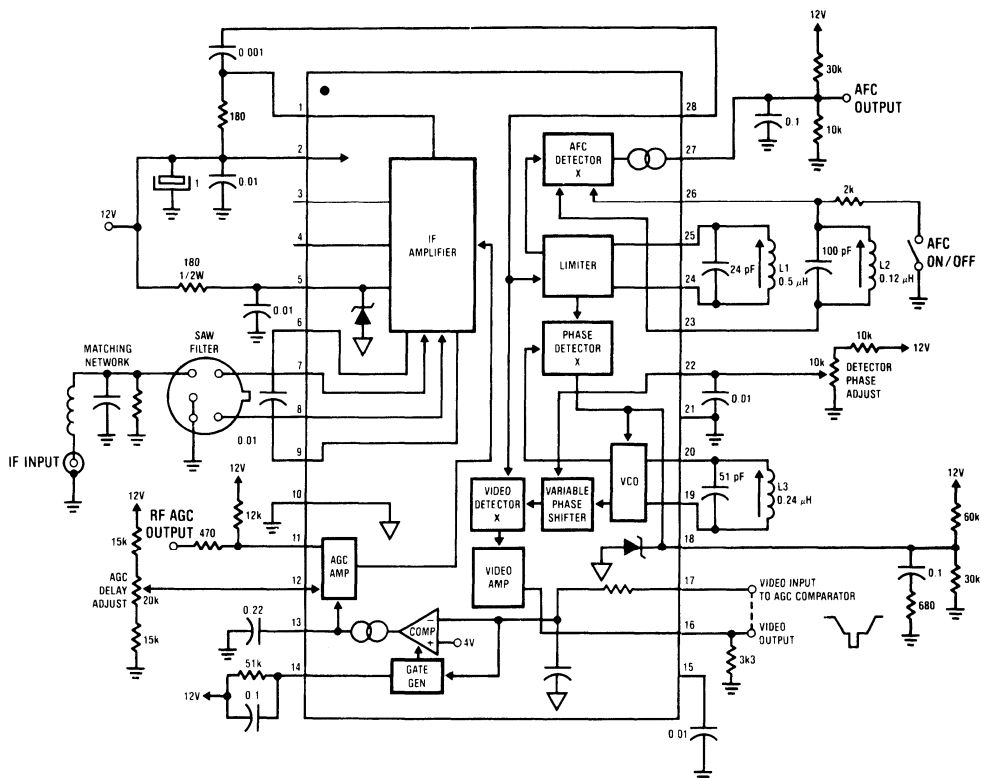
The I.F. amplifier is at full gain below 4 VDC on Pin 13. At anywhere from 5.5 VDC to 6.5 VDC we will want to shift gain control into the R.F. stages, and this is accomplished by a delayed AGC threshold control at Pin 12. When the filter voltage on Pin 13 is 0.7V above the pre-set level on Pin 12, the R.F. AGC amplifier at Pin 11 will start to sink current.

The capacitor shown connected between Pins 12 and 13 is optional and intended to provide an increase in AGC action

for signal amplitude transients at high R.F. signal levels (tuner in gain reduction). AC changes on Pin 13 are coupled to the threshold level control allowing the I.F. amplifier to gain reduce (or increase) during the signal transient. This happens only during the signal change, so that the detected video returns more rapidly to the proper output levels. Once signal equilibrium is restored, the appropriate gain balance between the R.F. and I.F. amplifiers returns.

CONCLUSION

This note has described a high quality video I.F. amplifier/detector combination that can provide excellent baseband video signals. A complete schematic of the external components required in such an application is shown in *Figure 32*, with a suitable p.c.b. layout in *Figure 33*.

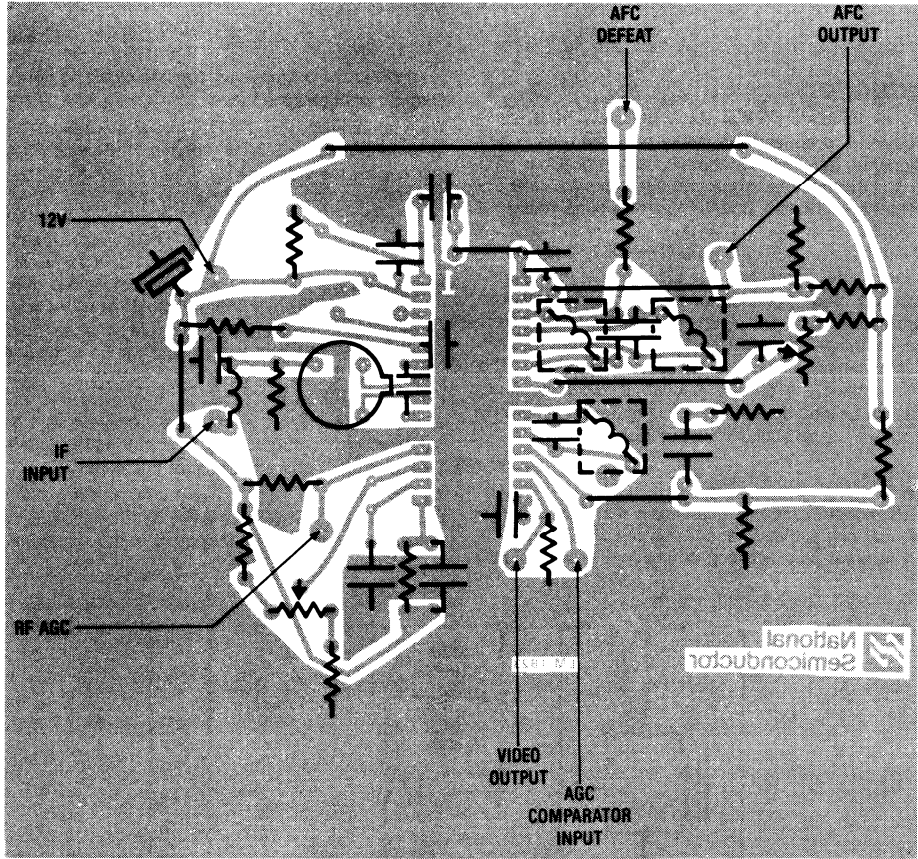


SAW Filter-MuRata SAF45MC/MA

L1-9 $\frac{1}{2}$ T } #22 wire
 L2-4 $\frac{1}{2}$ T } on 3.16" form with
 L3-6 $\frac{1}{2}$ T } HF core, shielded
 All caps in uF unless noted

FIGURE 32. LM1823 External Circuit Components

TL/H/8421-34



TL/H/8421-95

FIGURE 33. LM1823 Printed Circuit Board Layout (Component Side)

LM2889 R.F. Modulator

National Semiconductor
Application Note 402
Martin Giles



Introduction

Two I/C RF modulators are available that have been especially designed to convert a suitable baseband video and audio signal up to a low VHF modulated carrier (Channel 2 through 6 in the U.S., and 1 through 3 in Japan). These are the LM1889 and LM2889. Both I/C's are identical regarding the R.F. modulation function—including pin-outs—and can provide either of two R.F. carriers with dc switch selection of the desired carrier frequency. The LM1889 includes a crystal controlled chroma subcarrier oscillator and balanced modulators for encoding (R-Y) and (B-Y) or (U) and (V) color difference signals. A sound intercarrier frequency L-C oscillator is modulated using an external varactor diode. The LM2889 replaces the chroma subcarrier function of the LM1889 with a video dc restoration clamp and an internally frequency modulated sound intercarrier oscillator.

Modulation Parameters

In the U.S., either of two R.F. channels is made available so that the user can select a vacant channel allocation in his geographic area, thus avoiding co-channel problems with

older receivers that have inadequate shielding between the antenna input and the tuner.

The characteristics of the R.F. signal are loosely regulated by the FCC under part 15, subpart H. Basically the signal can occupy the standard T.V. channel bandwidth of 6 MHz, and any spurious (or otherwise) frequency components more than 3 MHz away from the channel limits must be suppressed by more than -30 dB from the peak carrier level. The peak carrier power is limited to 3 mVrms in 75 Ω or 6 mVrms in 300 Ω , and the R.F. signal must be hard-wired to the receiver through a cable. Most receivers are able to provide noise-free pictures when the antenna signal level exceeds 1 mVrms and so our goal will be to have an R.F. output level above 1 mVrms but less than 3 mVrms. Since the distance from the converter to the receiver is usually only a few feet, cable attenuation will rarely be a problem, but mis-termination can change both the amplitude and relative frequency characteristics of the signal.

The standard T.V. channel spectrum has a picture carrier located 1.25 MHz from the lower band edge. This carrier is amplitude modulated by the video and sync signal. In the

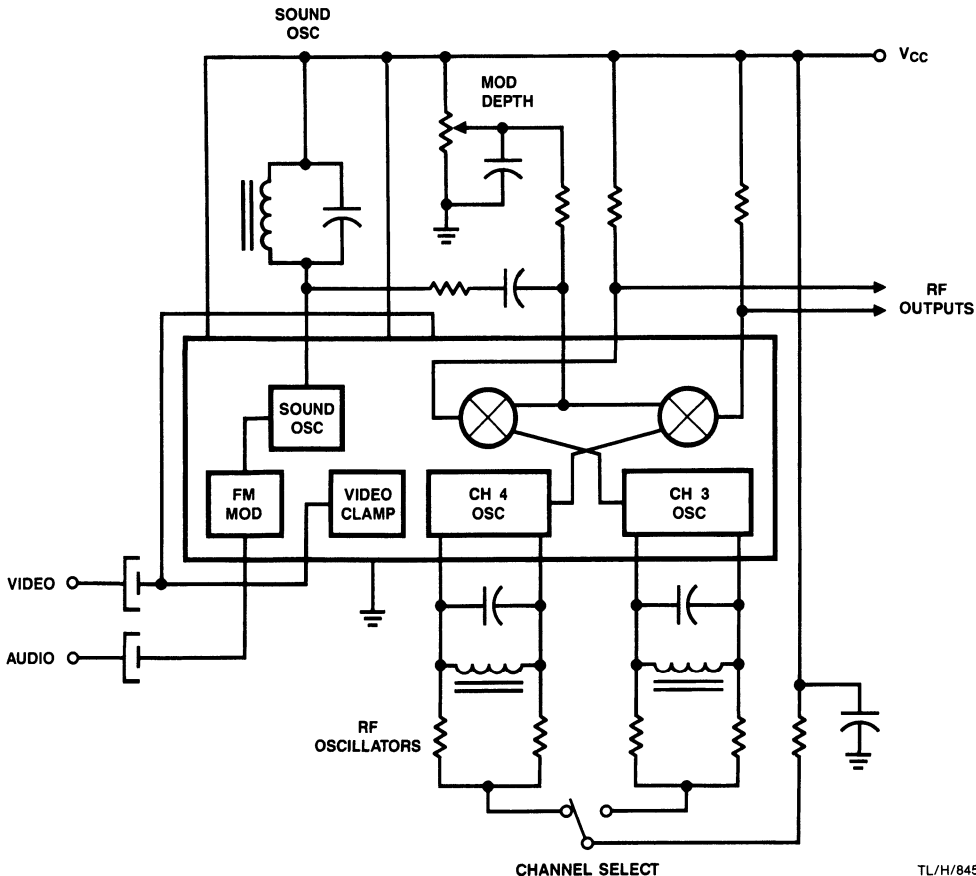
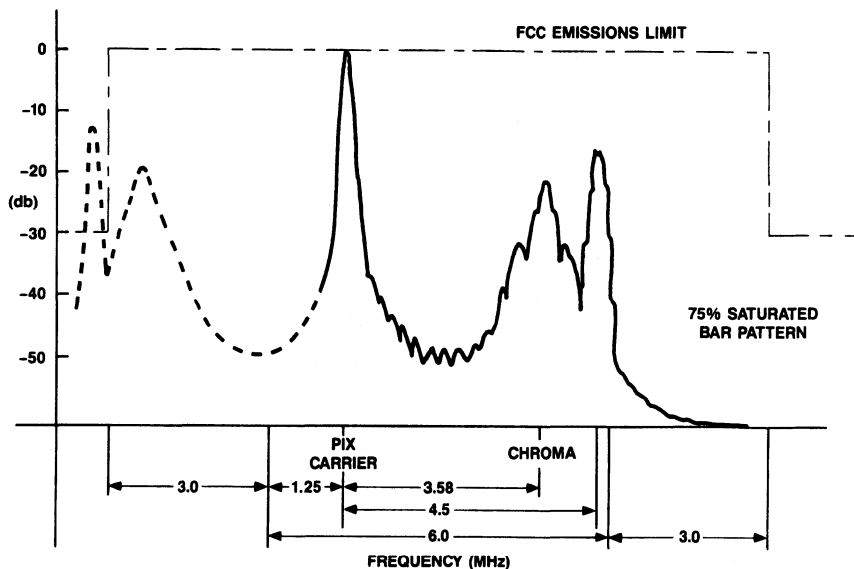


FIGURE 1. The LM2889 Block Diagram With External Components

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Modulation Parameters (Continued)



TL/H/8452-2

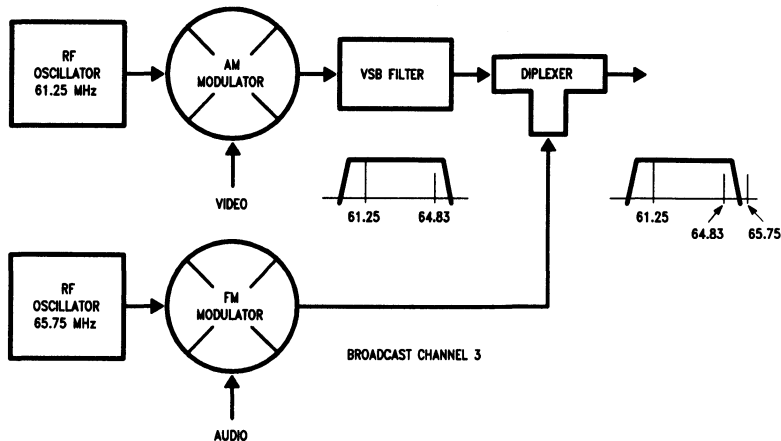
FIGURE 2. Television Channel R.F. Spectrum

case of a color signal, a second subcarrier is added 3.58 MHz above the picture carrier. The sound or aural carrier is 4.5 MHz above the picture carrier and is frequency modulated with the audio signal to a peak deviation of 25 kHz. This audio signal has pre-emphasis above 2.1 kHz (a 75 μ s time constant). Similar modulation methods and standards are used in Japan and Europe.

With the picture carrier located near one end of the channel bandwidth, most of the available spectrum is used by the upper sideband modulation components. Only modulating frequencies within 0.75 MHz of the carrier frequency are transmitted double sideband and the lower sideband is truncated by at least -20 dB compared to the peak carrier level by the time the lower channel edge is reached. This is referred to as Vestigial Sideband (VSB) modulation and since most R.F. modulators are double sideband, a VSB filter is used at the transmitter output. A filter is needed for each

channel and consists of bandpass and harmonic filter sections. A broadcast transmitter uses a separate modulator for the sound carrier and this is added to the picture carrier via a diplexer before reaching the transmitting antenna. Close control is maintained on the picture and sound carrier frequencies to keep a 4.5 MHz spacing between them. This tight frequency control is used to advantage by the majority of television receivers which employ intercarrier sound circuits. The I.F. amplifier processes both the pix and sound I.F. carriers and detects the 4.5 MHz difference frequency at the video detector stage. This frequency modulated sound intercarrier is then stripped of amplitude modulation by a high gain limiter circuit and a quadrature demodulator recovers the audio.

The LM1889 and LM2889 use a slightly different modulation scheme to that described above for several reasons. For circuit economy L-C oscillators are used to generate the pix



TL/H/8452-3

FIGURE 3. Broadcast Transmitter Block Diagram

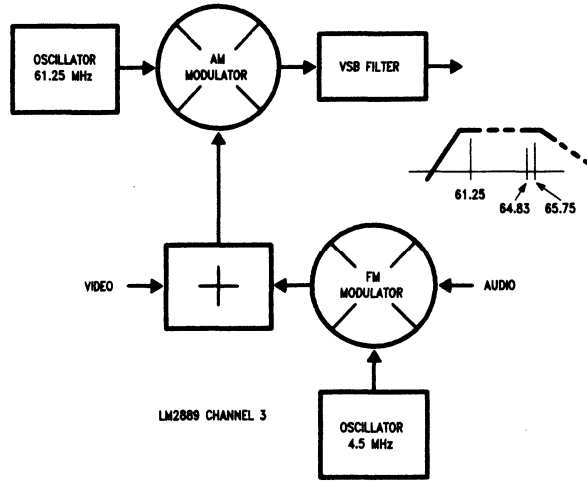


FIGURE 4. LM1889/2889 Sound and Video Modulation

carrier frequencies. The stability of such oscillators is good enough for the AFT circuits in modern receivers to maintain picture quality, but if a separate L-C sound carrier oscillator were used, the relative drift of the two carrier frequencies would be much too great for intercarrier sound receivers. For example, a typical television sound circuit tuned to 4.5 MHz will generate as much as 3% distortion if the difference between the R.F. carriers changes by 15 kHz. Apart from the difficulty of setting the initial frequency with sufficient accuracy, it is unlikely that two L-C oscillators could be kept within 15 kHz of each other at 60 MHz to 100 MHz operating frequencies. However, when the audio signal is modulated onto a 4.5 MHz intercarrier oscillator frequency and this carrier is used to modulate the picture carrier, we have only the 4.5 MHz oscillator drift to worry about.

A less obvious problem, but nevertheless significant if good audio quality is to be obtained, is incidental carrier phase modulation (ICPM). Even broadcast transmitters cannot maintain an invariant carrier phase as the modulation depth changes. Without feedback loops to control ICPM, a broadcast transmitter can produce from 3 degrees to as much as 30 degrees phase change as the carrier modulation decreases from sync tips to peak white. While the separate sound carrier is unaffected by this ICPM of the pix carrier, on reception in the intercarrier sound receiver the phase shift with picture information is transferred onto the 4.5 MHz sound intercarrier. This results in a phenomenon known as sound buzz. Even with exceptionally careful p.c.b. layout, an I/C modulator with L-C oscillators can expect the pix carrier frequency to change with modulation depth. Fortunately, by modulating the sound signal as a 4.5 MHz intercarrier onto the pix carrier, the ICPM occurs equally in both R.F. carriers and will not be detected by the intercarrier receiver.

Video Modulation

The baseband input to the modulator is in an easily recognized composite format and this is a convenient point at which to introduce the I.R.E. scale. This is an oscilloscope scale divided into 140 units. The video portion of the signal representing the scene (picture) brightness levels will occupy the 0 to 100 I.R.E. portion of the scale, with 0 I.R.E. as black level and 100 I.R.E. as peak white level. From 0 to

—40 I.R.E. is the synchronization portion of the signal. The usefulness of this scale is that the standard composite video signal will always have a sync amplitude that can be normalized to 40 I.R.E. Similarly the color burst amplitude is always 40 I.R.E. For a 1V (p-p) video signal, an I.R.E. unit is equivalent to 7.5 mV.

Although the video is amplitude modulated on the carrier waveform, the carrier amplitude only decreases from the unmodulated level. This contrasts with standard AM where the carrier level alternately increases and decreases about the unmodulated level. For a television signal, the peak unmodulated level corresponds to sync tip level and increasing brightness levels cause decreasing carrier levels. To prevent complete suppression of the carrier (and consequent loss of the sound intercarrier in the receiver) the peak white signal is limited to a maximum modulation depth of 87.5% of the peak carrier. Returning to our I.R.E. scale we can see that from peak carrier to zero carrier is equivalent to 160 I.R.E. ($140/0.875 = 160$). One obvious consequence of this modulation scheme is that the video signal MUST BE dc coupled to the modulator. AC coupling will cause the peak carrier level to change with modulation scene brightness (standard AM) and the sync modulation amplitude will change. This spells trouble for the receiver sync circuits and the changing R.F. carrier black level will cause errors in displayed brightness—the picture will “wash out” or disappear into black.

The LM2889 uses doubly balanced modulator circuits with an L-C oscillator switching the upper transistor pairs. The signal is applied across the lower transistor pairs. If the signal input pins 10 and 11 are at the same dc potential, the

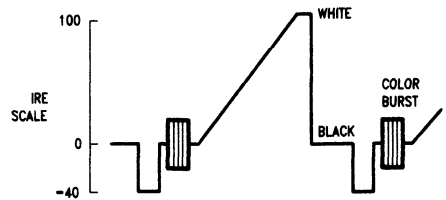


FIGURE 5. Video Modulating Signal (in terms of the I.R.E. Scale)

Video Modulation (Continued)

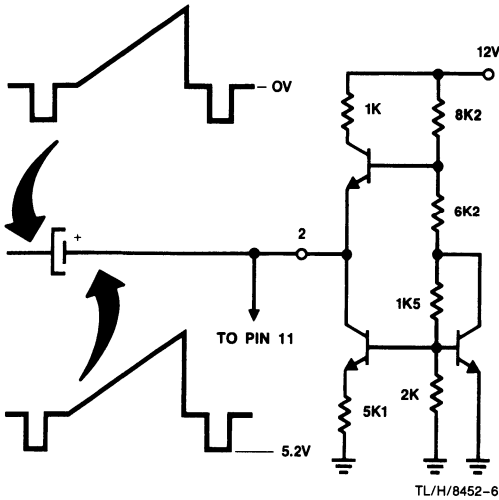


FIGURE 6. LM2889 Video DC Restoration Clamp

carrier is completely suppressed. As the offset voltage between pins 10 & 11 is increased, the carrier output level increases. With a 75Ω output load resistor, the conversion gain of the R.F. modulator is 20 mVrms/volt. A dc restoration circuit at pin 2 of the LM2889 allows the composite video to be ac coupled from the preceding stages, giving the designer flexibility in the video processing circuits (unless an LM1886 is being used as a video source, it is unlikely that the composite video dc level will be correct, even with dc coupled video sources). On a 12V supply, pin 2 clamps the sync tip of the video waveform to 5.1 VDC. Therefore, if we have a 2V (p-p) signal, one I.R.E. is equivalent to 14.3 mV and 160 I.R.E. is 2.29V. This is the required offset across the modulator input pins and since pin 11 will

be clamped to 5.1 VDC by the dc restorer circuit, pin 10 should be biased at $5.1V + 2.29V = 7.4$ VDC. A look at the R.F. carrier output will confirm that now the syncs occupy from 100% to 75% of the peak carrier, and that white modulates the carrier down to $12\frac{1}{2}\%$ of the peak. To maintain the proper modulation depth the clamp at pin 2 will track with supply voltage changes, allowing the bias at pin 10 to be set with a resistive divider connected between the supply and ground.

If the video signal polarity is reversed with positive syncs, either a dc coupled signal or an external dc restorer should be used that places the signal sync tip voltage towards the upper end of the common-mode input range at pin 11, which is 9 VDC with a 12V supply. Pin 10 is then offset below pin 11 voltage by the required amount for proper modulation. An input level of 2V (p-p) is optimal. Signal amplitudes of less than 1V (p-p) are also useable but internal offset voltages and the potential for carrier feedthrough or leakage to the output stage may make it difficult to maintain good R.F. linearity at peak modulation depths. Signal swings larger than 3V (p-p) should be avoided since this will produce relatively large AC/DC current ratios in the modulator and the resulting modulator non-linearities can cause a 920 kHz beat between the chroma and sound carriers.

Although only one video input is required, the LM2889 has two balanced R.F. modulators and two R.F. carrier frequency oscillators. Selection of the carrier frequency is by dc switching the supply voltage to the relevant oscillator tuned circuit. This automatically shuts off the other oscillator and modulator circuits. For test purposes when an output R.F. VSB filter isn't used, or when only one carrier frequency is needed, the output pins 8 and 9 can be wired together with a common load resistor. Providing two channel operation with two independent oscillator/modulator circuits is much superior to using a single modulator and attempting to change carrier frequency by switching the tuning components of a single L-C oscillator. The latter method involves

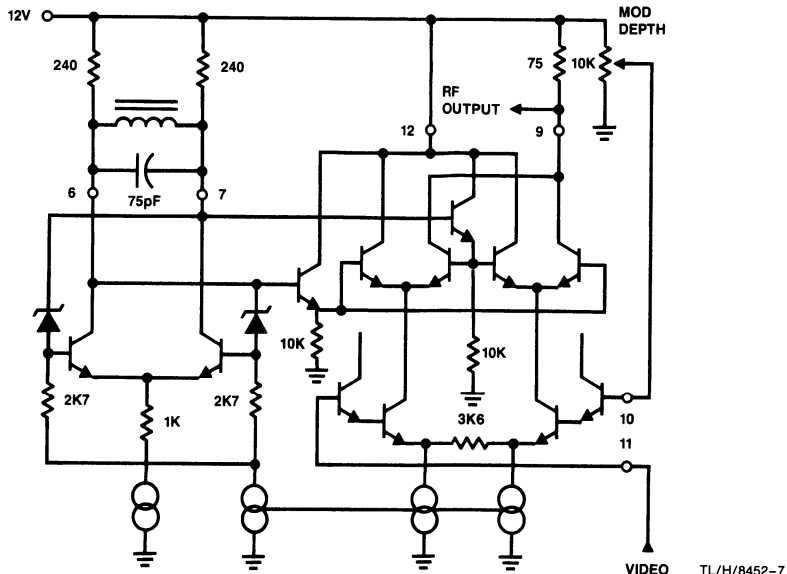


FIGURE 7. LM2889 R.F. Modulator and Oscillator (one channel)

Video Modulation (Continued)

use of isolating diodes (if unbalanced operation with attendant feed through problems is to be avoided) and expensive trimmer capacitors for tuning the second carrier frequency. A further disadvantage is the need to switch the VSB filter at the R.F. output.

The LM2889 oscillator configuration is the familiar cross coupled differential amplifier type, with level shifting zener diodes used to prevent the transistors from saturating with large oscillator output swings. The oscillator frequency is set by the tuned circuit components ($f = 1/2\pi\sqrt{LC}$), and the load resistors connected to the supply will set the oscillation amplitude and drive level to the modulators as well as determining the circuit working Q.

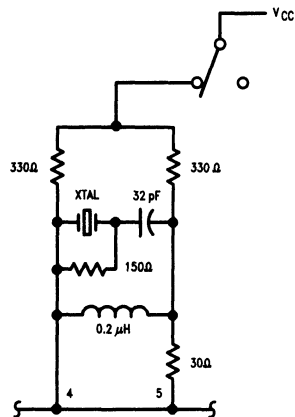
As might be expected, there are conflicting requirements on the practical range of working Q's. A high Q is desirable from the viewpoint of stability, but higher working Q's (set mainly by larger load resistors) increase the drive level to the modulator. Above 350 mV (p-p) the modulator will have attained full conversion gain and the R.F. output level will be determined by the amplitude of the video input signal. Unfortunately increased drive levels will also increase the carrier frequency second harmonic output from the modulator. Although a fully balanced design is used, parasitic capacitances on the emitters of the switching transistor pairs will rectify the oscillator waveform and this produces high levels of second harmonic. Load resistors much larger than 240Ω can produce a level of second harmonic matching the fundamental. Since relatively small load resistors are required (much smaller than the tuned circuit dynamic resistance) the working Q will be dominated by these resistors.

The acceptable degree of frequency stability will depend on the intended application, but L-C oscillators have proven to be adequate for most purposes. We can gain an idea of the frequency stability that is possible by considering the frequency drift produced by changes in the oscillator internal phase. A change in internal phase shift can be caused either by temperature or supply voltage changes but, as the LM2889 data sheet shows, the supply voltage dependency is low. Between 12V and 15V the frequency is essentially constant and changes by less than 30 kHz over the entire supply voltage range. With temperature, the internal oscillator phase shift changes by about 2 degrees over a 50 degree Celsius temperature range. If the tuned circuit Q is 15, then at 61.25 MHz (Ch 3 pix carrier) the oscillator frequency must change by -92 kHz to produce a compensating 2 degree phase shift. If the Q is 30, then the frequency would change by less than -45 kHz etc.

For high circuit Q, a large capacitance is desirable, but the inductor cannot be made too small if it is to remain the tuning element. This keeps the practical range of capacitance values to between 50 pF and 100 pF. Using a 75 pF capacitance, at 67.25 MHz the required inductance is just under 0.08 μH and the working Q is 15 with 240Ω resistors connected on either side of the tuned circuit to the supply voltage. Depending on the coil type, the number of turns for this inductance will be from 1½ to 3½ giving over 10 MHz tuning range. This is more than enough to compensate for component tolerance and variations in overall internal phase lag from 1/C to 1/C.

If better frequency stability of the carrier frequency over that provided by an L/C circuit is needed, then crystal control of the oscillators can be used. It is necessary to retain the inductor, since a dc short is required across the oscillator pins to avoid a collector current imbalance off-setting the

oscillator differential pair and preventing start-up. The inductor value is chosen to resonate with the capacitor in series with the crystal at slightly less than the desired operating frequency. About 20% less will allow the inductor to be fixed tuned. Close to its series resonant frequency (normally the 3rd overtone) the crystal will provide the additional inductive reactance necessary for the circuit to oscillate. The equivalent resistance of the crystal at the operating frequency will affect the tuned circuit Q and hence the peak-to-peak drive to the modulator circuit. Smaller capacitors in series with the crystal (with corresponding changes in the inductor value) will push the operating frequency closer to anti-resonance and produce large equivalent resistances dropping the oscillator drive level. Larger capacitance values cause the operating frequency to approach series resonance and a lower equivalent resistance (approaching R_S for the crystal, which is of the order of 40Ω to 100Ω at 60 MHz). This can produce higher drive levels but risks operation at the lower overtones. To prevent lower frequency oscillation a resistor can be connected across the crystal. Also a small resistor in series with one of the collector leads will form a low pass filter with the output capacitance and suppress spurious oscillations at higher frequencies. If this is needed, resistor values less than 30Ω should be used, so that dc offsets will not prevent the oscillator from starting. For the circuit of Figure 8, capacitor values between 20 pF and 56 pF, with the appropriate inductor value, work well with only slightly reduced oscillator drive compared to the conventional L/C circuit.



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FIGURE 8. R.F. Crystal Oscillator Circuit

The Sound Carrier Oscillator

Before moving to the R.F. output and the VSB requirements, we need to look at another signal that will be added to the baseband video—the aural intercarrier. Both the LM1889 and the LM2889 have L-C sound carrier oscillators operating at 4.5 MHz. Frequency modulation of the LM1889 sound oscillator is achieved by an external varactor diode which alters the tuning capacitance in response to the amplitude of the audio signal. The LM2889 has a similar tuned L-C oscillator but the frequency deviation is obtained by internally phase shifting the oscillator current. This is done by a low pass filter connected to the oscillator which provides a lagging phase voltage component of the oscillator waveform at the input to a differential amplifier. The current output from

Sound Modulation (Continued)

Clearly the deviation phase offset dominates the circuit Q requirement.

If we choose a Q of around 10 then the oscillator drift with temperature (assuming a 2 degree phase change in oscillator current with a 50 degree rise in temperature) is of the order of -9 kHz. A typical receiver will generate less than 3% distortion at peak deviations with this much frequency drift but if better performance is required, then the circuit Q can be raised. High modulation linearity will still be retained with a Q of 20 and the oscillator maximum frequency drift will be halved. Alternatively temperature compensated tuning capacitors can be used (between N20 and N75). When higher circuit Q's than 20 are employed, increased audio input levels will produce the desired peak frequency deviations but with the possibility of increased modulation distortion. The actual operating parameters that are selected can be balanced between distortion as a result of modulation, and distortion in the receiver circuits as a result of oscillator frequency drift.

To ensure that we have a sufficient 4.5 MHz oscillator level to provide enough drive to the internal phase shift circuit, the load impedance at pin 13 should be greater than 3.5 k Ω . A second requirement is that we have enough oscillator level to generate the desired aural carrier amplitude when modulated on the picture carrier. This means that load impedances greater than 6 k Ω are desirable. At 4.5 MHz, a typical oscillator coil of 23 μ H will have an unloaded Q of 55 and tune with 55 pF. For a working Q of 10, the external damping resistor is 7.5 k Ω .

Stereo Sound

The introduction in the U.S. of a multiplex stereo sound system (the BTSC system combining the Zenith MCS proposal with dbx noise reduction in the stereo difference channel) with peak carrier deviations in excess of 73 kHz puts even larger constraints on the tank circuit Q. Following the same rules as before, the maximum allowable Q for low distortion is now less than 7.4 —with a loaded Q of 5 being likely. With this loaded Q, maintaining a carrier center frequency accuracy better than 5 kHz with an L/C circuit becomes impractic-

cal and other methods to set the oscillator frequency must be used. Since a crystal will provide the necessary temperature and voltage stable reference frequency a PLL is a useful solution (see *Figure 11*). Either the widely available 3.58 MHz crystals or a 4.5 MHz crystal can be used, but in either case, the L/C tank circuit frequency must be divided down before application to the phase detector. This is because frequency modulation of the sound carrier will produce many radians of phase deviation at the phase detector input—for a modulation frequency of 100 Hz and a peak deviation of 73 kHz the carrier phase change is given by Equation 3.

$$\theta = \Delta f/fm = 73 \times 10^3/100 = 730 \text{ rads} \quad (3)$$

Since the linear input range of most phase detectors is less than 2π radians, the modulated carrier input must be divided down by at least 233 to keep the phase deviation within this linear range. For a 4.5 MHz crystal, the reference frequency divider M and the sound oscillator divider N are the same. Available ripple counters such as the 74HC4040 and 74HC4060 can easily divide by 128 (for monaural) or by 256 for stereo. If a 3.58 MHz crystal is used the M:N divider ratio is 35:44 requiring substantially more packages, and the odd numbered divider must be followed by an even divide of 2 or 4 to "square up" the input waveform to the phase detector. Also, since the video will include a chroma subcarrier, good isolation is needed to prevent the reference oscillator beating with the chroma sidebands.

A suitable phase detector is the 74C932 Exclusive-Or type with a sensitivity of 1.6 volts/radian. The filter at the detector output prevents the input modulation from reaching the varactor diode and distorting the audio. Even so, the loop filter must have some ac bandwidth for a reasonable acquisition time and other dynamic characteristics. The components shown in *Figure 11* have been chosen such that with a varactor sensitivity of 100 kHz/volt the loop has a hold-in range of over ± 150 kHz, with a lock-up time of less than 0.5 seconds. The T.H.D. is less than 1% for a 400 Hz modulating frequency producing 25 kHz deviation of the carrier. The accuracy of the sound carrier frequency is, of course, that of the crystal used for the reference oscillator.

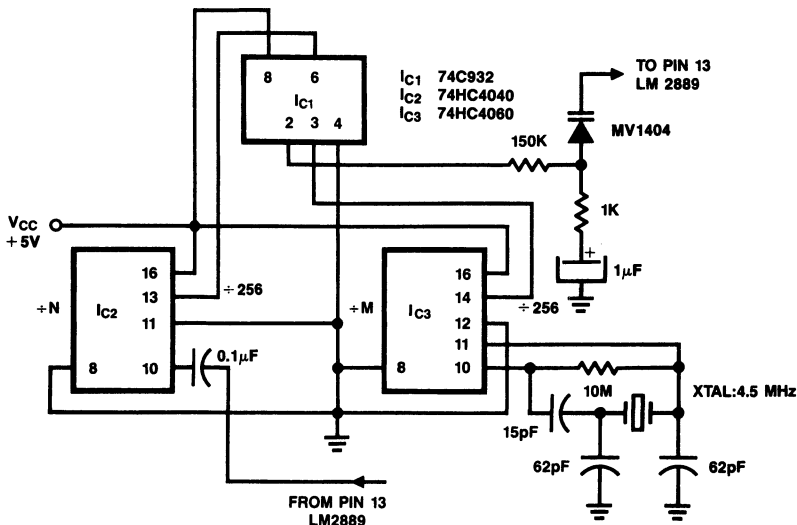


FIGURE 11. 4.5 MHz Crystal Reference Circuit

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Audio Processing For Sound Carrier Modulation

With the proper tuned circuit Q (see Table I), a linear increase in the amplitude of the audio signal will produce a correspondingly linear increase in the frequency deviation. Television receiver sound circuits in the U.S. have a $75 \mu\text{s}$ de-emphasis and in Europe frequencies above 3.2 kHz (50 μs) are de-emphasized at a 6 dB/octave rate. This is done to help improve the S/N ratio of FM reception and the transmitter incorporates the complementary pre-emphasis characteristic—above 2.1 kHz the audio frequencies are boosted at a 6 dB/octave rate. The consequence of this modulation scheme is that if a 0 dB peak signal amplitude at 15 kHz is capable of producing a 25 kHz deviation than a similar amplitude signal at 400 Hz will produce a peak deviation of only 3 kHz—a loss of some 18 dB in S/N ratio for the midband frequencies. Broadcasters usually employ compressors to enable high modulation levels to be obtained at mid-band frequencies without overmodulating high frequencies. If the audio input to the LM2889 is being sourced from an original broadcast (a scrambled signal decoder output for example) than this audio—without de-emphasis—can be directly applied to pin 1 of the LM2889, and the overall input level is adjusted so that the modulation limits are not exceeded except for brief intervals (less than 10 instances per minute). When the audio has not already been processed a different set of conditions will apply and an audio pre-emphasis network is required at pin 1.

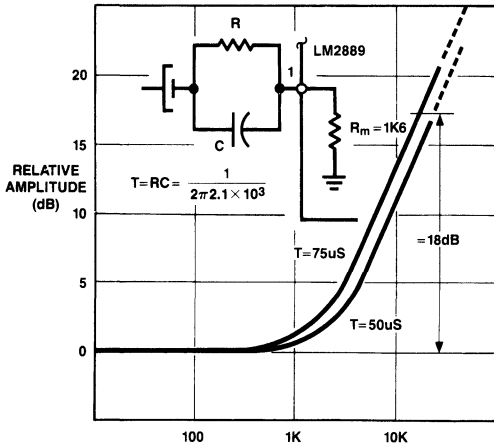


FIGURE 12. Audio Pre-emphasis

Since the audio source is likely to be at a relatively low impedance (a pre-amplifier output), the pre-emphasis network will also be used to attenuate the level of the average audio input to the LM2889 as well as providing a relative boost to the higher frequencies. The input sensitivity of the audio modulator is 150 Hz/mV which means that 118 mVrms will give a peak deviation of 25 kHz.

Next we have to decide what signal frequency and amplitude to use in calibrating the audio input. Unfortunately the 75 μs time constant for FM broadcasting was chosen at a time when equipment limitations meant there was relatively low spectral energy at higher frequencies. Today, modern audio material is not well suited to boosting above 2.1 kHz since energy peaks at only -6 dB can be obtained at 10 kHz. A further complication is the ability of the audio level meter to predict high energy peaks. If a conventional VU

meter is used, peak levels of $+10 \text{ dB}$ are possible while the meter is indicating OVU. Obviously without processing the audio to keep it within predetermined limits, the input level calibration will be somewhat empirical in nature.

If we assume the decrease in spectral energy above 10 kHz is such that overmodulation peaks above this frequency are unlikely to occur, then we can allow a signal at 10 kHz to produce full modulation deviation. Since the amplitude of most audio signals at 10 kHz is at least 6 dB below the midband frequency level, we can calibrate the audio input with a -6 dB amplitude, 10 kHz tone to produce 100% deviation. As we shall see later, a frequency close to 10 kHz will make the measurement of actual peak deviations very easy indeed. With the standard pre-emphasis network, at signal frequencies less than 2 kHz, the modulating signal amplitude at pin 1 will be -8 dB below the anticipated peak 10 kHz level producing 100% modulation. This corresponds to a modulator input level of $118/2.2 = 45.4 \text{ mVrms}$. The

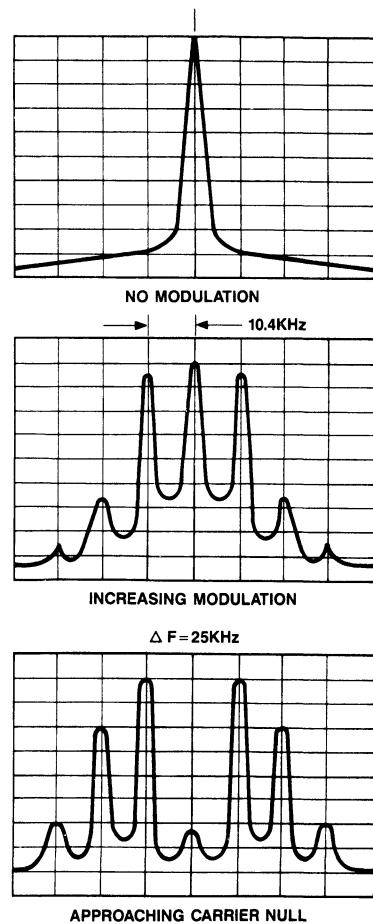


FIGURE 13. FM Spectrum with Increasing Audio Amplitude (f mod = 10.4 kHz) 4.5 MHz Sound Carrier Level

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Audio Processing For Sound Carrier Modulation (Continued)

input resistance at pin 1 is 1.5 kΩ so R1 = 30 kΩ, if we assume an input source level of 1 Vrms at 400 Hz. For a 2.1 kHz breakpoint, C = 0.0027 μF.

Anyone who has observed the output from an FM circuit with a spectrum analyzer will know that for a fixed modulating frequency the output spectrum will consist of the carrier frequency component and sidebands spaced by the modulating frequency from the carrier. As the modulation amplitude is increased (the modulation index m becomes larger), the carrier decreases to a null and then increases again. The modulation indices for which carrier nulls occur can be calculated and for our purposes it is important to know that the first carrier null occurs at m = 2.4048. For a system maximum deviation of 25 kHz the modulating frequency f is given by:

$$f = 25 \times 10^3 / 2.4048 = 10.4 \text{ kHz} \quad (4)$$

Therefore, if we use an input frequency of 10.4 kHz, as the input amplitude is increased the first carrier null will indicate peak deviation. If we continue with our assumption of a -6 dB level at 10 kHz, calibration consists of adjusting the audio input so that a -6 dB, 10.4 kHz signal causes the first carrier null. With the above pre-emphasis network, this should correspond to 500 mVrms at 10.4 kHz.

We have already looked at the tuned circuit parameters at pin 13 in terms of deviation linearity and oscillator stability. With a working Q of 10, the effective load at pin 13 is 6.2 kΩ. The oscillator current is 0.45 mA so that the output amplitude at 4.5 MHz is 3.6V (p-p). Some portion of this oscillator signal level is coupled over to pin 10 to set the sound carrier level and this can be done by splitting the external 7.5 kΩ damping resistor into two parts. The picture carrier level is set by the offset voltage between pins 10 and 11 as described earlier. For a 2V (p-p) video signal this offset is 2.3V. Since the 4.5 MHz signal will be ac coupled over to the bias pin 10, it will amplitude modulate the picture RF

carrier. This is conventional AM and a 4.6V (p-p) signal will yield sound carrier sidebands at -6 dB relative to the picture carrier. If we require a sound carrier amplitude at -17 dB, the signal coupled to pin 10 must be 11 dB below 4.6V (p-p), or 1.3V (p-p). This is obtained by using a 4.7 kΩ resistor coupled through a 0.1 μF capacitor to pin 10, and a second 2.7 kΩ resistor connected to the wiper arm of the potentiometer used to set the video modulation depth. The effect of the potentiometer setting on the aural carrier level is eliminated by a 0.1 μF capacitor connected from the wiper arm to ground. However, since the impedance presented by the potentiometer will, for all practical purposes, be relatively constant, the capacitor could be removed and the parallel resistance of the upper and lower arms of the potentiometer network used to provide the second resistor of 2.7 kΩ. If the video input level is well controlled, it may be possible to replace the potentiometer with a fixed divider.

The final part of the design concerns the output stage, and involves meeting the constraints applied by any regulatory agency. In the U.S., apart from the need to restrict the peak carrier output level to less than 3 mVrms in 75Ω, we have two signals present in the output whose level will exceed the spurious emission limit of -30 dB with respect to the peak carrier level. One of these signals is the result of amplitude modulating the 4.5 MHz intercarrier audio on the picture carrier. Apart from the desired -17 dB sound carrier amplitude (upper sideband) an equal amplitude lower sideband will be present. For channel 3 this is at a frequency of 56.75 MHz—which is 250 kHz outside our channel lower limit. Therefore we need to provide at least 13 dB more attenuation at this frequency in the output filter. The second unwanted emission (or emissions) is the result of carrier frequency harmonics—specifically the 2nd harmonic level produced by high modulator drive. To suppress this, from -18 dB to -30 dB attenuation at 123 MHz is required.

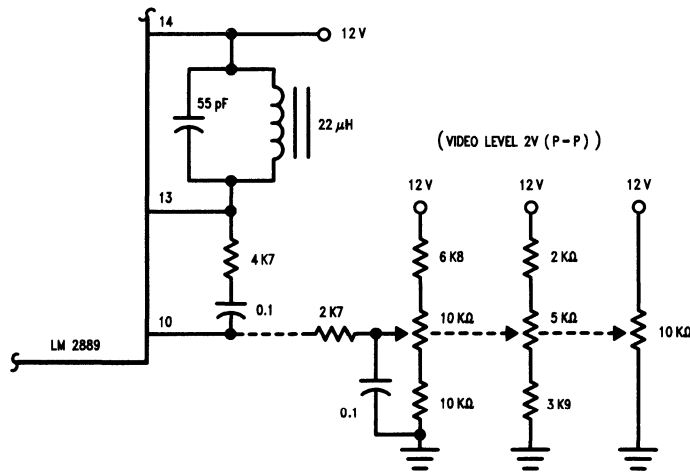


FIGURE 14. Audio Intercarrier Coupling to the Video Modulator R.F. Output and V.S.B. Filter

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Audio Processing For Sound Carrier Modulation (Continued)

With a properly constituted baseband signal modulating the carrier, these are the only intrinsic unwanted emissions we are concerned with. Normal video modulation components appearing in the lower sideband will not have sufficient amplitude and do not extend beyond the lower channel limit. Even so, the filter requirements are not trivial.

If L-C filters are used, this can be done with three coils per channel but some alignment procedure will be required. Fortunately SAW filters are available from several sources which, although more expensive than the equivalent L-C filter, avoid the cost of production alignment. Usually the SAW filter will have a substantially greater insertion loss, but the LM2889 has enough output level to compensate for this. Both single channel and dual channel filters are available and in the latter case the LM2889 dual oscillator/modulator configuration enables easy dc switching between channels. A coil may be required, connected across the SAWF input, to tune out the SAWF input capacitance.

The load resistors connected to pins 8 and 9 will set the LM2889 conversion gain, which for 75Ω is typically 20 mVrms R.F. carrier per volt offset at the input pins 10 and 11. The actual load will include the input resistance of

the filter. Since the output of the filter will normally be terminated in 75Ω to match the cable (and provide triple transit echo suppression for a SAWF), the best way to choose the load resistor is to monitor the output to the cable and apply a dc offset between pin 10 and 11 that is equivalent to the expected video input. The resistor is then chosen to give the desired peak carrier level of 2.5 mVrms. The carrier should be unmodulated since downward modulation will reduce the mean carrier level by as much as 2-3 dB.

If the offset voltage between pin 10 and 11 is reduced, a check can be made on the residual carrier level at the output. This residual level is the result of oscillator feedthrough in the modulators and external coupling from the oscillator tuned circuits. The residual carrier level is normally better than -26 dB below the peak carrier level, ensuring good modulation linearity. High levels of residual carrier can be caused by coupling through ground or power supply leads. A good technique to minimize the effect of unwanted pick-up is to decouple the supply voltage to pin 8 and 9 load resistors over to the output connector shield ground. This removes at the output any carrier signal on the supply line to the load resistors.

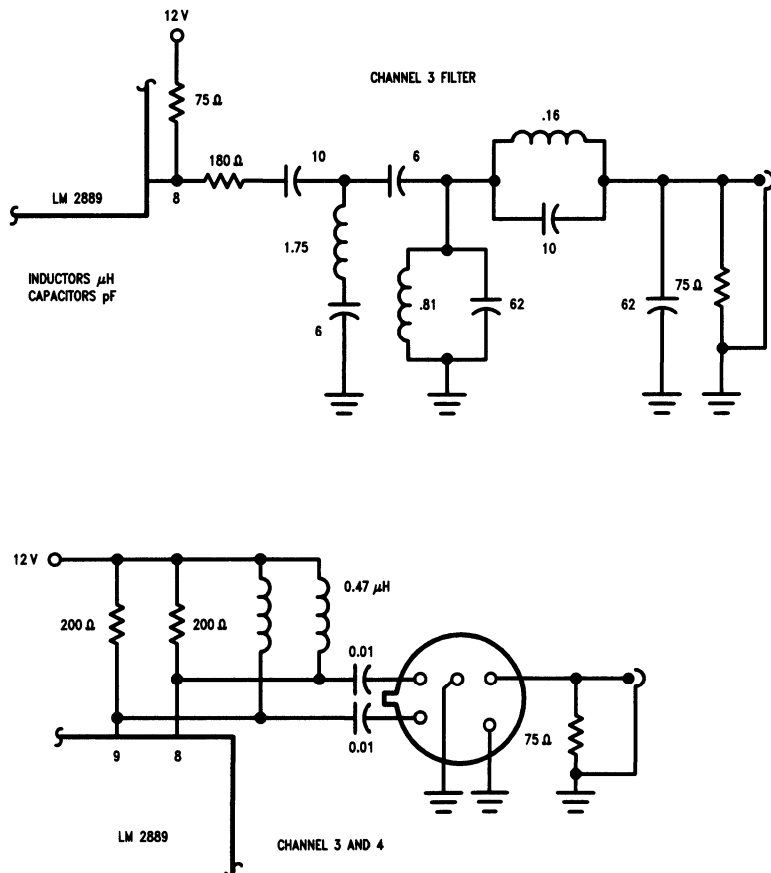


FIGURE 15. Vestigial Sideband Filters

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Audio Processing For Sound Carrier Modulation (Continued)

Sources: SAWFs

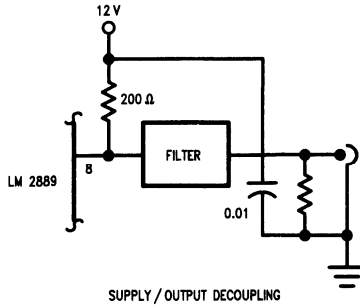
Crystal Technology, Inc.
 1035 E. Meadow Circle
 Palo Alto, CA 94303
 Kyocera International, Inc.
 8611 Balboa Ave.
 San Diego, CA 92123
 MuRata Corp. of America
 1148 Franklin Rd. S.E.
 Marietta, GA 30067

CRYSTALS

Saronix
 4010 Transport at San Antonio Rd.
 Palo Alto, CA 94303

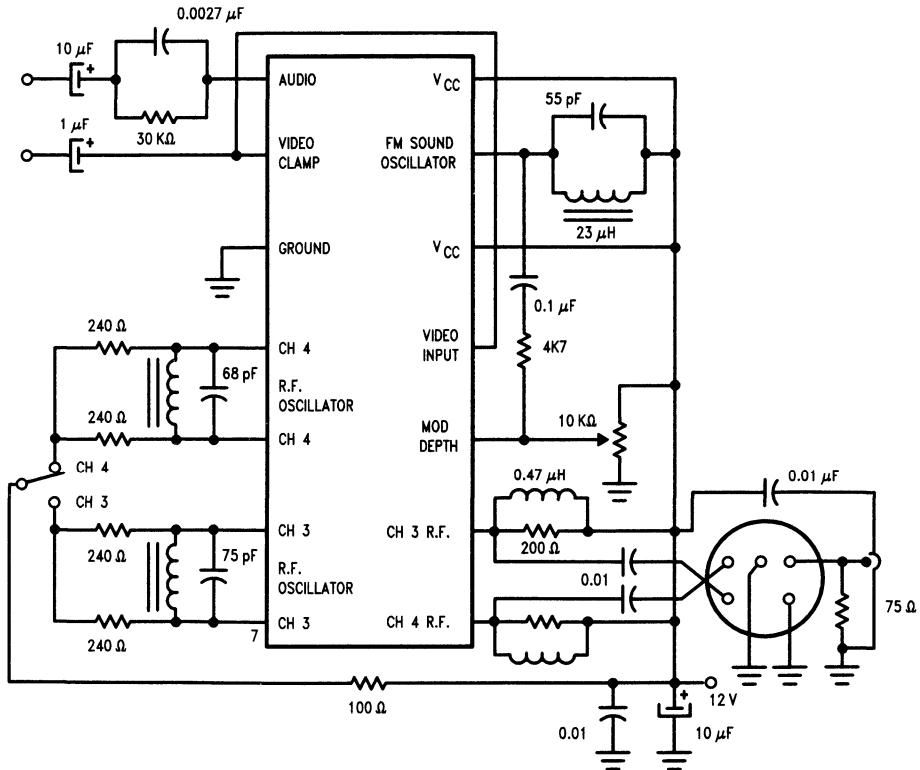
COILS

Toko America, Inc.
 5520 W. Touhy Ave.
 Skokie, Ill. 60077



TL/H/8452-16

FIGURE 16. R.F. Decoupling at the Output



TL/H/8452-17

FIGURE 17. Complete R.F. Modulator External Circuit

DC Coupled Tape Head Pre-amplifiers

National Semiconductor
Application Note 407
Martin Giles



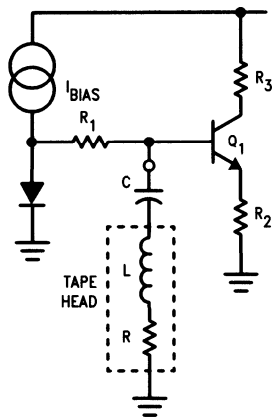
AN-407

INTRODUCTION

The majority of tape-head pre-amplifier I/C's use a-c coupled inputs. This is convenient in that it requires only one lead from each individual tape-head coil be brought to the pre-amplifier input – i.e. dc coupling the head to the amplifier. However, a-c coupling the signal from the head has a number of disadvantages that can be eliminated by taking the existing leads from both sides of the coil to the pre-amplifier input – i.e. dc coupling the head to the amplifier. The LM1897 is a dual tape-head pre-amplifier designed for audio cassette playback with d-c coupled inputs. A similar I/C, the LM1837, has four input stages in order to accommodate auto reverse cassette playback mechanisms that do not mechanically alter the position of the playback heads when the direction of the tape motion is reversed. Electronic switching is used to select the correct pair of heads. This application note describes the problems eliminated by d-c coupling the heads, and the advantages obtained by the unique two amplifier per channel design of the LM1897 and LM1837.

A-C COUPLING VERSUS D-C COUPLING

The problems that occur with a-c coupled tape-head pre-amplifiers are easily demonstrated by referring to *Figure 1* which shows a typical input stage Q_1 that is biased through the resistor R_1 . The tape-head, modelled as an inductor with a series resistance, couples to the base of Q_1 through capacitor C.

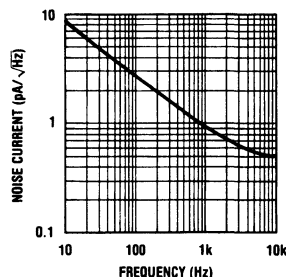


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FIGURE 1. Input Stage of a Capacitor-Coupled Tape Head Preamplifier

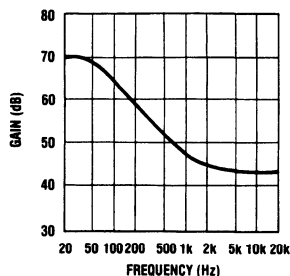
Since the input impedance of the amplifier is of the order of 50 k Ω the capacitor must be at least 0.32 μ F if a -3 dB lower corner frequency of 10 Hz is desired. As it happens, the capacitor is normally from 30 to 100 times this value because of noise considerations, although a small value for C is desirable from the viewpoint of keeping turn-on times short.

Dealing with noise first, there are three major contributors to the input referred noise; the noise voltage generated by the resistive component of the head impedance, the input noise voltage of the I/C – including the noise contribution from the resistive feedback network which sets the overall gain, and the input noise current of the I/C multiplied by the source impedance which includes the reactance of the input coupling capacitor. At low frequencies, below 1 KHz, the amplifier noise current (and noise voltage) increases as the frequency decreases as shown in *Figure 2*. Further, the amplifier gain for correct tape playback equalization is also increasing as the frequency decreases, *Figure 3*. Of course the reactance of C is increasing too. Since the head resistance is typically of the order of 50 Ω to 300 Ω , C will dominate the low frequency source impedance and therefore have a major impact on the noise voltage at low frequencies. At 10 Hz our previously calculated value of C has a reactance of 50 k Ω , which is more than 100 times the head resistance! To avoid this causing an increase in low frequency noise we can increase the value of C but this may



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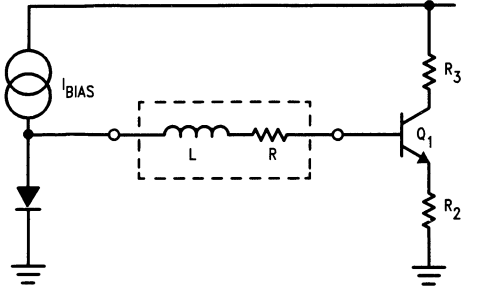
FIGURE 2. Input Noise Current versus Frequency for an I/C Preamplifier



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FIGURE 3. Tape Amplifier Playback Equalization Characteristic

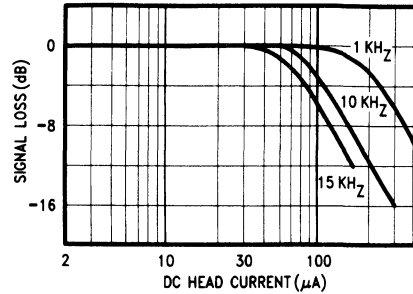
give us a turn-on time problem. At turn-on, the coupling capacitor must charge to at least 0.7 volts before the input stage Q_1 is biased on. If we choose $C = 100 \mu\text{F}$ to minimize low frequency noise, the turn-on time will be over 10 seconds, obviously an unacceptable result. Although special turn-on circuits can be employed to rapidly charge the coupling capacitor at turn-on (see LM1818 data sheet) the amount of quick charge current has to be restricted in order to prevent the initial current transient in the head coil putting a turn-on "blip" on the tape. Without fast turn-on circuits, most designs accept a compromise value for C of around $10 \mu\text{F}$.



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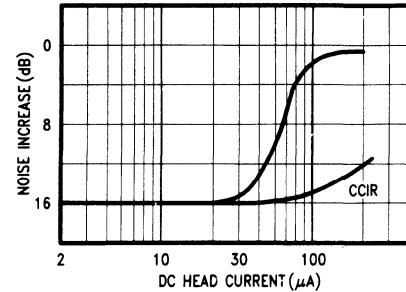
FIGURE 4. Direct-Coupled Preamplifier Input Stage

The alternative to a-c coupling is d-c coupling as shown in *Figure 4* where both leads from the playback head coil are brought to the pre-amplifier. C is completely eliminated as are the problems described above, but now we have to be concerned about the effects of a constant bias current for Q_1 which is also flowing through the tape-head. It is well known that dc current in the playback head can not only cause erasure of high frequency information recorded on the tape, but it may also generate an increase in the noise level. To determine the effects of dc head currents with a typical audio cassette playback head, we made a number of measurements with signal tones recorded on the tape at 1 kHz, 10 kHz, and 15 kHz. The tapes used were standard bias ferric formulation tapes, representative of medium priced blank tapes and many pre-recorded tapes. Premium tapes were not used since these are generally characterized as having higher coercivity and are therefore less susceptible to high frequency signal erasure. *Figure 5* shows the effect of increasing the dc current when a tape recorded with these tones at an initial flux level of 20 nW/m (approximately 20 dB below the 0 "VU" level) is played up to 100 times. Clearly if the current is under $30 \mu\text{A}$, very little high frequency erasure is occurring. Similarly, the increase in tape noise with increasing head current is shown in *Figure 6*, again after 100 plays. Two methods of measuring the



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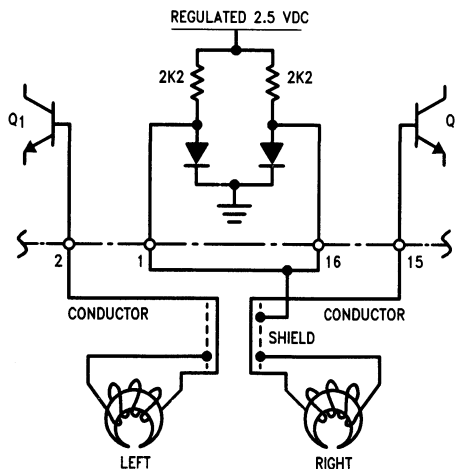
FIGURE 5. Signal Loss as a Function of DC Head Current



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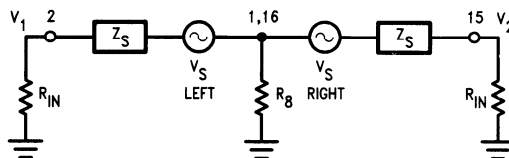
FIGURE 6. Increase in Tape Noise as a Function of DC Head Current

noise level were used, a narrow band measurement between 20 Hz and 200 Hz, and a broadband weighted measurement (CCIR/ARM) which is popular in the tape recorder industry for giving good correlation to our perceived audible sensitivity to broadband random noise. Notice that the increase in noise level does not occur until the head dc current is sufficient to already cause some high frequency erasure. The collector current for the LM1897 input transistor is optimized at $70 \mu\text{A}$ for good low-noise performance, which results in an input bias current of $0.5 \mu\text{A}$. Worst case the bias current is only $2 \mu\text{A}$ which is still an order of magnitude less than the current level needed to cause either high frequency erasure or an increase in tape noise. Therefore, it is reasonable to conclude that dc coupling the head is a viable solution to the problems caused by input coupling capacitors.



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FIGURE 7. Two Conductor Plus Shield Head-To-Preamplifier Connection



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FIGURE 8. Equivalent AC Circuit for Two Heads with a Common Bias Point

MAKING THE CONNECTION

Although we have eliminated the cost of the input electrolytic coupling capacitors and the performance problems associated with these capacitors, we now have to bring both sides of the head coils to the inputs of the LM1897. This can be done as shown on the LM1897 data sheet, where a 4 conductor (stereo) shielded cable is used, and the shield is grounded to the p.c.b. ground. This type of connection is ideal in high electrical noise field environments, but many cables have only two conductors within the shield. In this case the method shown in *Figure 7* can be used where the shield provides the bias current return path for both pre-amplifiers. Even though the output impedance of this common bias point is about 100Ω, this is sufficiently low to provide effective noise shielding in most applications. However, because the bias point is common to both amplifiers, this same 100Ω impedance could introduce crosstalk between the two tape head signals. The equivalent a-c circuit is shown in *Figure 8*, where the tape signals are represented by the voltage sources V_1 and V_2 and Z_S is the tape head impedance. The crosstalk V_2 to V_1 is given by Equation (1)

$$V_2/V_1 = R_B / (R_B + Z_S + R_{IN}) \dots \dots \dots (1)$$

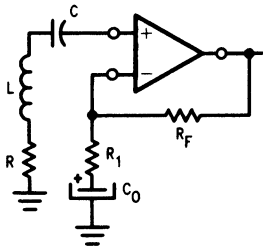
R_B is 100Ω, and R_{IN} is 50 kΩ, so the worst crosstalk will occur at low frequencies when Z_S is the smallest. If we

assume $Z_S = 0$, this gives a crosstalk figure of -54 dB, which is still 14 dB below the minimum guaranteed channel separation for the I/C. Since in practice most tape heads will have a minimum resistance between 50Ω and 500Ω, the actual crosstalk will be even less than that derived above, so the connection method of *Figure 7* should not contribute any problems.

THE AMPLIFIER GAIN STAGES

Neglecting (for the moment) the frequency equalization characteristic required of the tape head pre-amplifier in order to conform to the N.A.B. and D.I.N. playback standards, the amplifier must have enough gain to raise the signal voltage induced in the head coil to at least 100 mVrms. For a typical cassette head output of 0.5 mVrms this requires a voltage gain at 1 kHz in the range of 46 dB.

Although this much gain can easily be obtained with a single stage amplifier, the LM1897 uses a two-stage design. The reasons for this can be arrived at by considering the design of the usual single stage amplifier circuit of *Figure 9*. Apart from requiring the large input coupling capacitor, this design has other deficiencies. Usually the feedback resistors are external to the I/C to allow modification for different gain requirements, operating supply voltages and for the appropriate equalization network. R_F and R_1 set the a-c gain while C_o ensures that there is no gain to the dc offset volt-



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FIGURE 9. Conventional Single Stage Head Preamplifier

ages that may exist at the amplifier inputs and which could otherwise force the output dc quiescent voltage to ground or the positive supply rail. Because the signal source impedance is relatively low (the tape head) the resistor R_1 must be small to avoid providing a significant noise contribution at the input to the amplifier (see pp 2-5 of the Audio Radio Handbook, National Semiconductor, 1980)—values between 30Ω and 150Ω are common. Unfortunately, the dc blocking capacitor C_0 will also set a signal low frequency limit in conjunction with this resistor and if R_1 is small, then C_0 has to be large. Electrolytic capacitors greater than $47\mu F$ are common, and a trade-off between low noise, good low frequency response and cost is involved. Worse yet, at turn-on the capacitor is at ground potential, holding the amplifier inverting input low. The output immediately swings to the positive supply rail while the capacitor is charged up through R_F and R_1 . When it reaches the same voltage as the non-inverting input, the output will return to the normal quiescent dc value, approximately halfway between supply and ground. Unless output muting circuits are used, the initial output transient to the supply rail will produce a nasty pop or thump from the speakers!

Now take a look at the two stage amplifier used by the LM1897. The first stage gain is fixed at $\times 25$ by the internal $3.6\text{ k}\Omega$ and 150Ω feedback resistors, and the quiescent dc output voltage is set by the voltage V_x established across the 150Ω resistor.

$$V_x = V_{be}(Q2) + \frac{R_B}{R_A + R_B} \times V_{be}(D1) - V_{be}(Q1) \dots (2)$$

The emitter areas of transistors Q1 and Q2 are ratioed so that Q_1 current is 1/7th that of Q_2 , i.e.

$$\begin{aligned} V_{be}(Q1) &= V_{be}(Q2) - KT/q \times \log_7 7 \\ &= V_{be}(Q2) - 50\text{ mV} \dots (3) \end{aligned}$$

The divider of R_A to R_B is such that

$$R_B/(R_A + R_B) \times V_{be}(D1) = 40\text{ mV}$$

thus giving a voltage drop V_x of 90 mV across the 150Ω resistor. Therefore the output dc voltage is 2.2V and this can be held within $\pm 400\text{ mV}$. Following this fixed gain first stage is a second amplifier stage with the gain set by external components. Using two amplifiers ensures that high closed loop gains are possible with very low distortion over the audio frequency range. Again ignoring the equalization components for the moment, Figure 11 shows the biasing scheme that is used between the amplifiers to provide high ac gain, yet low dc gain to input offset voltages. The resistors R_2 and R_3 will determine the closed loop ac gain of the second stage, and R_3 and R_5 will similarly set the output quiescent dc voltage. Since the first stage will hold the non-inverting input at 2.2V, the second stage output voltage is given by Equation (4)

$$V_{OUT(DC)} = 2.2(1 + R_3/R_5)\text{ volts} \dots (4)$$

Usually this voltage is chosen to be halfway between supply and ground in order to maximize the output swing capability of the amplifier and minimize the possibility of input offset voltage causing dc offsets at the output which could allow clipping to occur. At turn on, the capacitor C_0 holds the non-inverting input at ground potential so that the output will also be at ground. The output will stay low until the capacitor is charged up close 2.2V dc, when the amplifier will turn on and bias the output to the normal quiescent value determined by Equation 4. Turn-on pops are completely eliminated and the signal turn-on delay is set by the R_1C_0 time constant. R_1 and R_2 are normally equal valued to minimize input offset currents producing dc offset voltages at the output but both resistors can be quite large. Large resistors will allow either inexpensive non-electrolytic capacitors to be chosen for C_0 , or extremely low -3 dB corner frequencies to be used - much lower than those obtainable by the con-

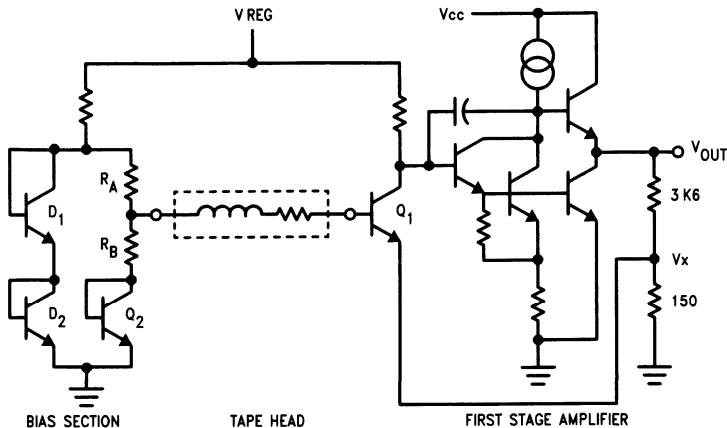
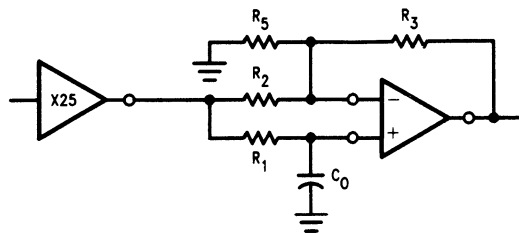


FIGURE 10. LM1897/LM1837 Input Stage Amplifier

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FIGURE 11. First and Second Stage Coupling Network

ventional amplifier of Figure 9. The corner frequency and turn-on delay are given by Equation (5) & (6) respectively.

$$f - 3 \text{ dB} = 1 / (2 \pi R_1 C_0) \dots \dots \dots (5)$$

$$\text{Turn on delay } t = R_1 C_0 \ln \{ R_3 R_5 / R_2 (R_3 + R_5) \} \dots \dots \dots (6)$$

For example, with $R_1 = 10 \text{ k}\Omega$ and $C_0 = 10 \mu\text{F}$, the turn-on time is 0.4 seconds, and the low frequency corner is 1.6 Hz. It is possible to use such large values for R_1 and R_2 because the noise contribution of R_2 in the signal path is made insignificant (compared to the source noise) by the first stage gain. A $10 \text{ k}\Omega$ resistor adds less than 0.13 dB to a 500Ω source noise level in the circuit of Figure 11, whereas a similar value resistor in the circuit of Figure 9 would increase the noise level by almost 14 dB! A further advantage is that since R_2 does not have to be small, greater flexibility is gained in selecting the necessary component values for the appropriate tape equalization characteristic.

SETTING UP THE EQUALIZATION

A typical tape pre-amplifier will have a gain of around 46 dB at 1 kHz and equalization time constants of $3180 \mu\text{s}$ (50 Hz)

and $120 \mu\text{s}$ (1326 Hz). Using the component arrangement shown in Figure 12, the required design equations are given in order below;

$$A_v = 46 \text{ dB} = 200\text{V/V at } 1 \text{ kHz (given)} \dots \dots \dots (7)$$

$$R_1 = R_2 = 10\text{k (arbitrary choice)}$$

$$C_1 = 4.8 \times 10^{-3} / R_2 (A_v) \dots \dots \dots (8)$$

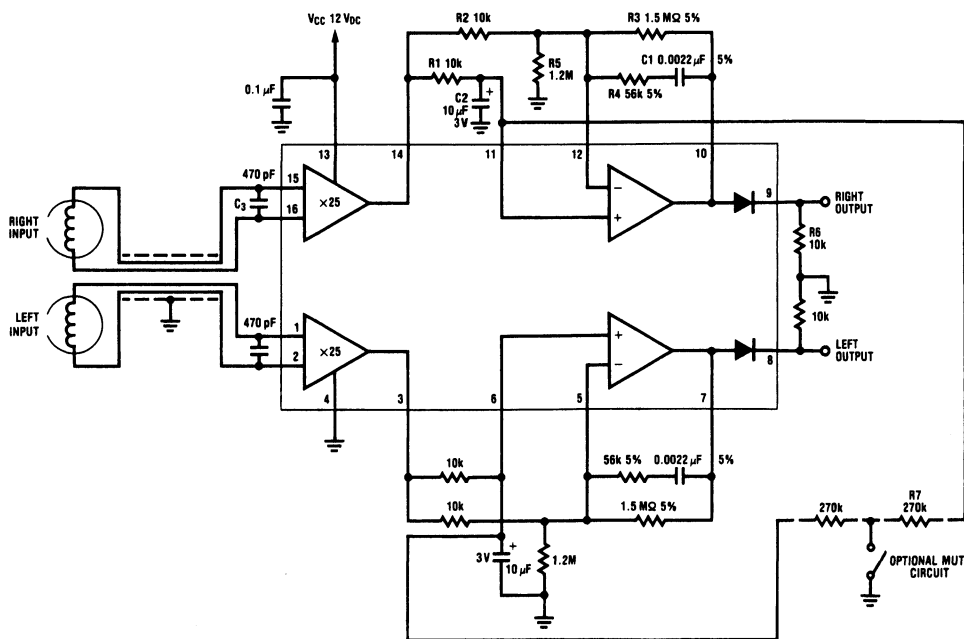
$$R_3 = \frac{1}{2} \pi C_1 (50) - \frac{1}{2} \pi C_1 (1326) = \frac{1}{2} \pi C_1 (51.96) \dots (9)$$

$$R_4 = \frac{1}{2} \pi C_1 (1326) \dots \dots \dots (10)$$

This provides the proper equalization for ferric formulation tapes. For chromium dioxide tapes, the value of R_4 is switched to

$$R_4 = \frac{1}{2} \pi C_1 (2274) \dots \dots \dots (11)$$

Although there should be a corresponding and simultaneous change in the value of R_3 , if this is not done it introduces an error of less than 0.2 dB in the low frequency response. Using these equations, we arrive at the component values shown in Figure 12. Equation (4) has been used to determine the value of R_5 .



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FIGURE 12. Complete External Components for the LM1897

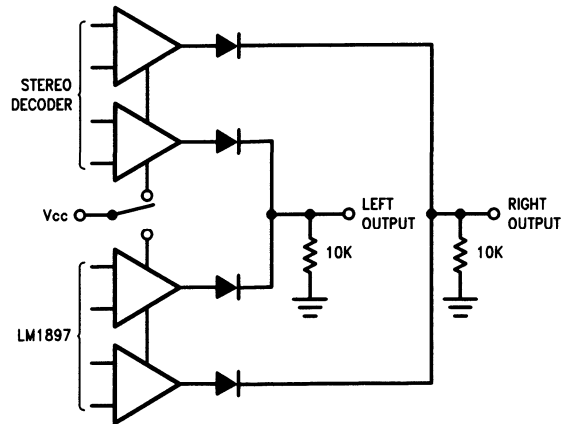


FIGURE 13. Diode Switching Between Sources

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THE OUTPUT DIODES

Although the pre-amplifier outputs are directly available, the LM1897 has two extra pins coupled to these outputs via diodes. If the signals are taken from these pins, the diodes facilitate switching between the different sources available in an automotive radio. For example, if the FM stereo decoder has similar diodes in the output of each channel, then the source outputs can be summed in common load resistors (Figure 13). When the FM stereo decoder output is desired, the power supply to the LM1897 is removed and the diodes in series with the output become reverse biased, thus isolating the LM1897 from the stereo decoder. During tape play, the LM1897 applies a positive potential on the load resistors, thus reverse biasing the diodes from the stereo decoder, which now has its power supply switched off. While this type of source switching is popular in automotive radios, the diode places a resistance in series with the output that will change slightly with ac signal current swings and may result in higher THD. Load resistors larger than 47 k Ω should not be used. Similarly, since the minimum guaranteed current capability of the LM1897 is 2 mA, the load resistor should be larger than 2 k Ω —a good compromise value is 10 k Ω .

FOUR HEADS ARE BETTER THAN TWO

Auto reverse cassette decks, capable of playback with the tape moving in either direction, are of two types. Either a normal stereo head is used with mechanical repositioning of the head over the desired audio tracks, or a four-track head is used with only the desired pair of head coils being switched to the pre-amplifier at any given time. The LM1837, which uses the same dc coupled, two stage amplifier design as the LM1897, includes two extra input amplifiers specifically for such four-track head, auto reverse cassette decks. A logic input is provided to select the pair of input amplifiers required for each direction of tape travel.

While this method of switching head coils is easy and convenient, it can present one problem. When pairs of input preamps are changed, any difference in the dc output levels of the amplifiers may produce a speaker pop during the transition period. This can be prevented by slowing up the switching time of the logic pin by adding an RC filter to the logic input (Pin 13) as shown in Figure 14.

One other minor point, the capacitors shown connected across each head coil are used to resonate with the head inductance. This allows compensation for playback signal losses caused by the tape head gap and eddy currents. The resonant frequency is usually somewhere between 13 and 17 KHz.

CONCLUSIONS

This application note has described the use of two dual tape pre-amplifier I/C's that use dc coupled head inputs. Combining this feature with a two stage amplifier design has made high system gain with low distortion throughout the audio bandwidth easily attainable. Low cost external components are used and turn-on pops have been eliminated. In addition, the LM1837 makes head selection in auto reverse decks an easily implemented function. Characteristics common to both I/C's when used in the circuits of Figures 12 and 14 are listed in Table I.

TABLE I. Features of the LM1897 and LM1837

Programmable Turn-on Delay	(0.4 secs typical)
Low Distortion	0.03% @ 1 kHz
Good S/N Ratio	62 dB (CCIR/ARM)
High G.B.W.	76 dB @ 20 kHz
Low Voltage Operation	4 volts (min)
High Power Supply Rejection	> 95 dB
High Channel Separation	60 dB
Short Circuit Protection	
No Turn-on Pops	
Low Cost External Components	
Diodes for Switching Applications	

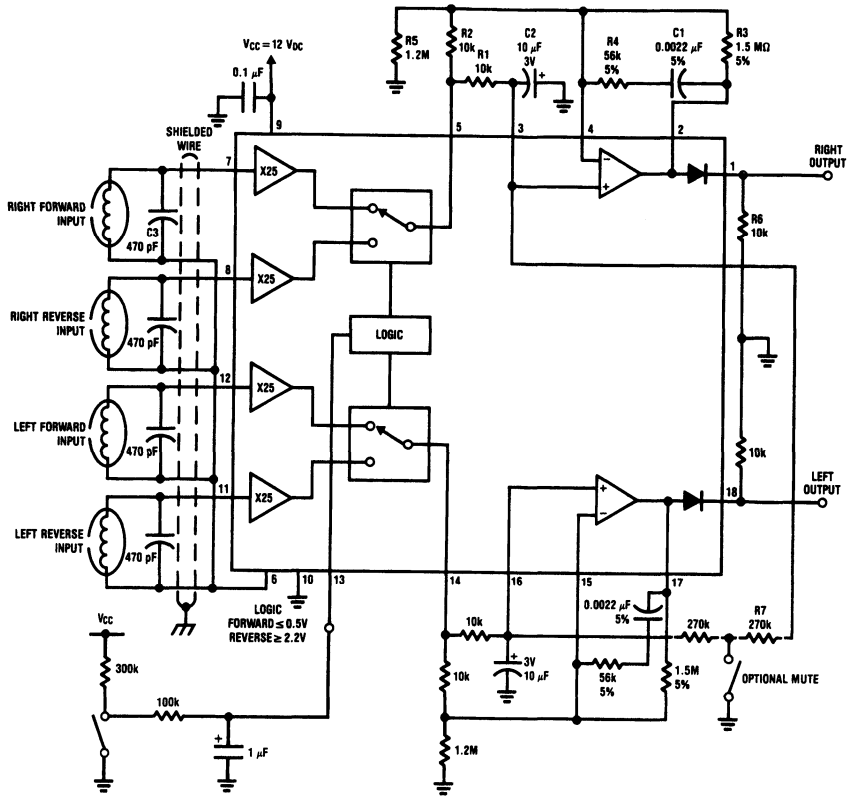


FIGURE 14. Input Stage Switching of the LM1837

TL/H/8519-14

Preserving and Verifying the LF400's Fast Settling Time

National Semiconductor
Application Note 428
Kerry Lacanette
Kevin Hoskins



INTRODUCTION

Settling to within 0.01% of a 10V output swing in well under 400 ns, the LF400 is a superb choice for a wide range of precision high-speed applications. However, care must be taken in both the design and the layout of high-speed circuits using the LF400 if the desired performance is to be realized. It is easy to significantly degrade the settling time with a seemingly minor layout error. A few guidelines for preserving the LF400's excellent settling time are listed below and illustrated in *Figure 1*. All of these apply to other operational amplifiers as well, but they become increasingly important as the speed of the circuit increases.

- 1) Minimize capacitance at the summing junction.** Any parasitic capacitance between the inverting input and ground, whether from the socket, circuit board traces, input cables or another source will produce a pole in the amplifier's feedback loop, altering the closed-loop transfer function and possibly inducing ringing.
- 2) Choose the compensation capacitor carefully.** The feedback pole caused by input capacitance must be compensated with an external capacitor across shunt feedback resistor R2. If this capacitor is too small, the amplifier output may ring, increasing the settling time. If the capacitor is too large, the settling time will increase due to the decrease in closed-loop bandwidth. The optimum capacitance will depend on the circuit components and board layout and often must be found experimentally. A good starting point is in the neighborhood of 10 pF. *Figure 2* shows the results of using too much or too little compensation capacitance. These effects are exaggerated for the purpose of illustration. Even when they are too small to be visible on the scale shown in *Figure 2*, they can degrade the speed at which the amplifier settles to 0.01% of full scale.
- 3) Use adequate supply bypassing.** Many good amplifiers have power supply rejection ratio (PSRR) specs in the 80 dB to 100 dB range, but these numbers are valid only at low frequencies. Since PSRR drops with increasing frequency, supply rejection at 1 MHz can be close to 0 dB. Thus it is essential to place bypass capacitors on the amplifier's supply pins to keep the ac impedance low, thereby reducing the amplitude of any supply variations. Note that the amplifier itself is a major cause of supply variations: when its output is moving, the supply currents change, thereby modulating the supply voltages. At high frequencies, where PSRR is low, these supply variations behave like small input signals. The result is an additional feedback signal path, which will in turn degrade the settling time.

Multiple bypass capacitors are nearly always necessary for good high-speed performance. Three are shown in the recommended test circuit in *Figure 3*: a 10 μ F tantalum, a 2.2 μ F ceramic, and a 0.47 μ F ceramic. If a 2.2 μ F ceramic capacitor is not used, a second 0.47 μ F ceramic can give satisfactory results if it is oriented so that its ground lead is separated from that of the first 0.47 μ F ceramic. This "spreads" the high frequency bypass current flow, resulting in lower effective bypass impedance.

The capacitors should be connected to the amplifier with very short leads. They should be as close to the supply pins as possible.

- 4) Use good grounding techniques.** Keep the ground return paths short to minimize their impedance. This is especially important for the supply bypass capacitors and the feedback components. When fast settling is important, use a ground plane approach such as that used in the test circuit layout (*Figure 4*).
- 5) Never use inductive feedback resistors.** Inductance will degrade loop stability.
- 6) Avoid excessive amplifier loading.** The LF400 can drive heavier loads than most operational amplifiers, but keeping the load resistance above 1k or 2 k Ω is good practice when settling time is critical. Minimizing load capacitance will also help the settling time.
- 7) Keep feedback resistance low.** Lower resistances (within the constraints imposed by the amplifier's load driving abilities), will minimize the effects of parasitic capacitances. The feedback components should have short leads.
- 8) Look out for external noise sources.** Nearby circuits with fast rise times, such as digital components or other high-speed analog circuitry, can couple unwanted signals into the amplifier, either capacitively or through common ground traces. Physically separate any such noise sources from critical high-speed circuits.

VERIFYING FAST-SETTLING PERFORMANCE

The LF400's settling time can be checked using the circuit in *Figure 3*. The amplifier is set up for inverting unity gain and its output is summed with the input signal using resistors R3 and R4. A "perfect" amplifier's output would be exactly the negative of the input and would result in 0V at the junction of R3 and R4. Any deviation from perfection will yield an error voltage at this "false summing node". The error signal is clamped by the two Schottky diodes and buffered by the JFET source follower. The purpose of the clamp diodes is to reduce the amplitude of the error signal fed into the oscilloscope. When a 10V pulse is applied to the amplifier input, the error will initially be 5V, and if this signal is not clamped, it will certainly overdrive the oscilloscope's input circuitry if the oscilloscope's input gain is high enough to detect a 1 mV error (0.01% of 10V). The input signal is loaded by two 100 Ω resistors in parallel. Note the extensive bypassing on all sensitive nodes.

A printed circuit board layout (2x) for the above circuit, capable of measuring the LF400's settling time is shown in *Figure 4*. Input and output BNC connectors should be soldered directly to the circuit board. The output connector should go directly to the oscilloscope input with no intervening cable.

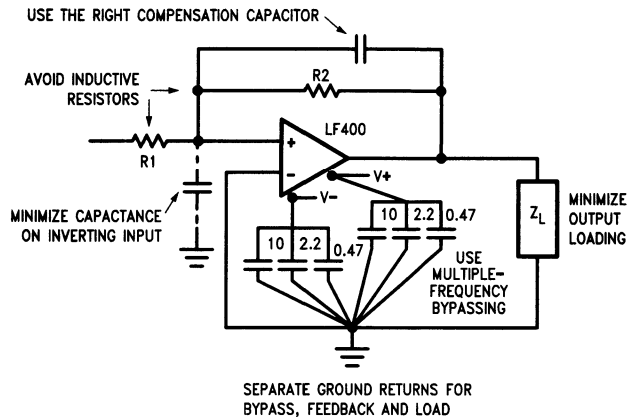
Because of attenuation by R3 and R4, the error signal displayed on the oscilloscope will be one half of the true error. When measuring settling with a 10V signal swing, a 1/2 mV displayed error signal will therefore represent 0.01% (1 mV) actual error. Even though the error voltage is diode-clamp-

ed, it is still high enough to overdrive the input amplifier of most oscilloscopes when the input amplifier is set to the 5 mV/division range. When this happens, the overload recovery time of the oscilloscope can be much longer than the op amp's settling time, making the measurement meaningless. Oscilloscopes with sufficiently fast overload recovery time for this measurement appear to be quite rare. Two oscilloscopes that have given satisfactory results with the circuit in *Figure 3* are the Tektronix 547 with the 1A1 plug-in and the Tektronix 7704A with the 7A18 plug-in.

The signal source is just as important as the oscilloscope and the circuit layout. It must be able to drive a 50Ω load to ±5V, and ideally should settle to within 1 mV of these voltage levels much faster than the amplifier being tested. In practice, however, the pulse generator's settling characteristics needn't be nearly that good, so long as any perturba-

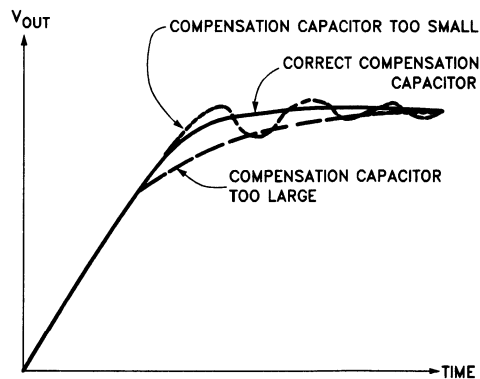
tions on the pulse are slow enough to be cancelled at the false summing node. Most generators that prove to be inadequate are disqualified on the basis of either insufficient output swing or excess output noise. The Systron Donner 101C and the Hewlett Packard 8082A pulse generators were found to give satisfactory results. Note that, as with the oscilloscopes, these do not represent an extensive sampling of available units.

To measure settling time using the test circuit, set the oscillator for ±5V output swing at about 10 kHz. Observe the error output on the oscilloscope, (*Figure 5*) and find the time required for the error voltage to be within ½ mV of the final value. This is the settling time to 0.01%. The input signal perturbations visible in *Figure 5* were not actually present at the test circuit input. They are a result of overload in the oscilloscope's input amplifier caused by the error signal.



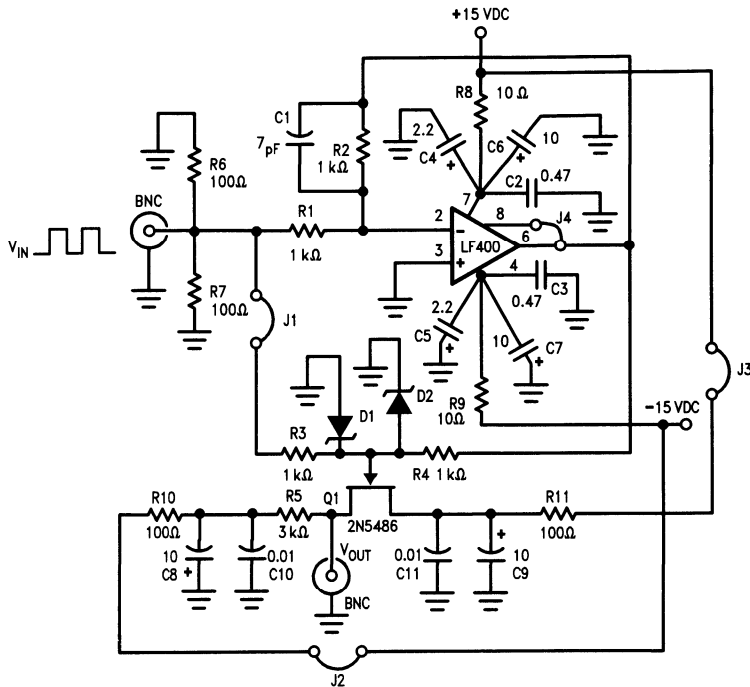
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FIGURE 1. Guidelines for Preserving High-Speed Amplifier Performance



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FIGURE 2. Effect of Compensation Capacitance on Amplifier Step Response



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FIGURE 3. Settling Time Test Circuit

Parts List

R1-R4 1 kΩ, 1% metal film; matched to 0.01%

R5 3 kΩ, 5% carbon film

R6, R7 100Ω, 5%, 1/2 watt carbon film

R8, R9 10Ω, 5%

R10, R11 100Ω, 5%

All resistors are 1/4 watt except where specified otherwise.

C1 7 pF, ceramic disk

C2, C3 0.47 μF, ceramic

C4, C5 2.2 μF, ceramic

C6-C9 10 μF, dipped-radial lead tantalum

C10, C11 0.01 μF ceramic

D1, D2 Schottky diode, Hewlett Packard # 5082-2810

Q1 2N5486 N-channel FET

Misc: Cinch-TRW # 8-ICS 8-pin TO-5 socket, gold-plated pins,
2 BNC connectors

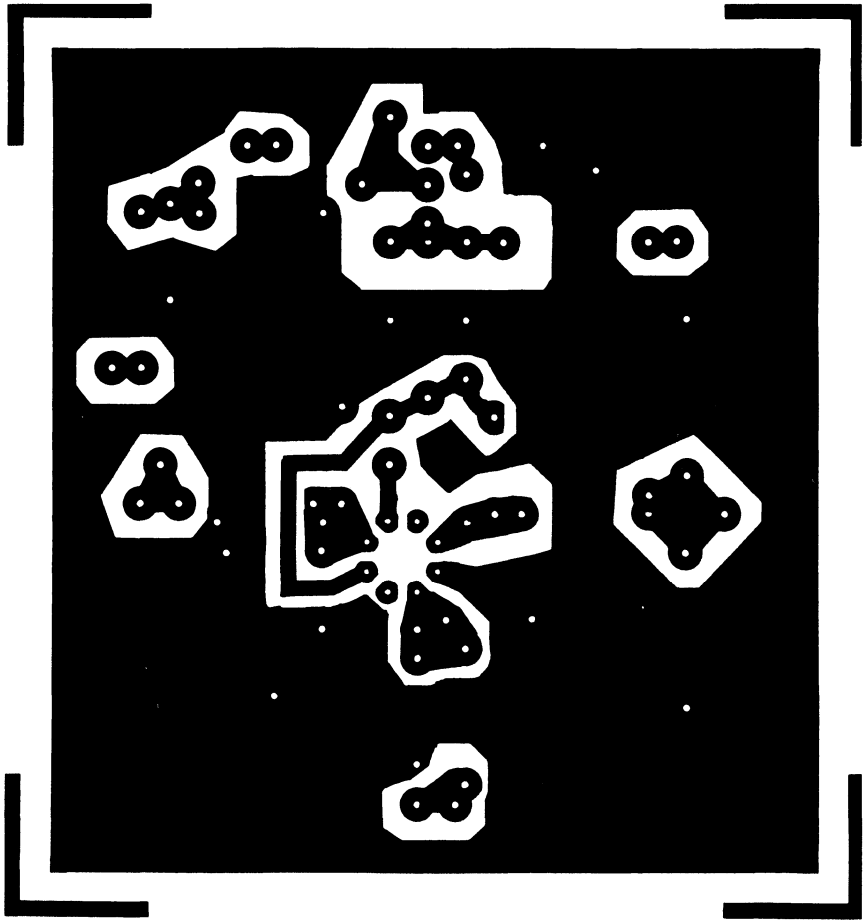


FIGURE 4a. Printed circuit board layout for LF400 settling time test circuit. Foil side is shown.

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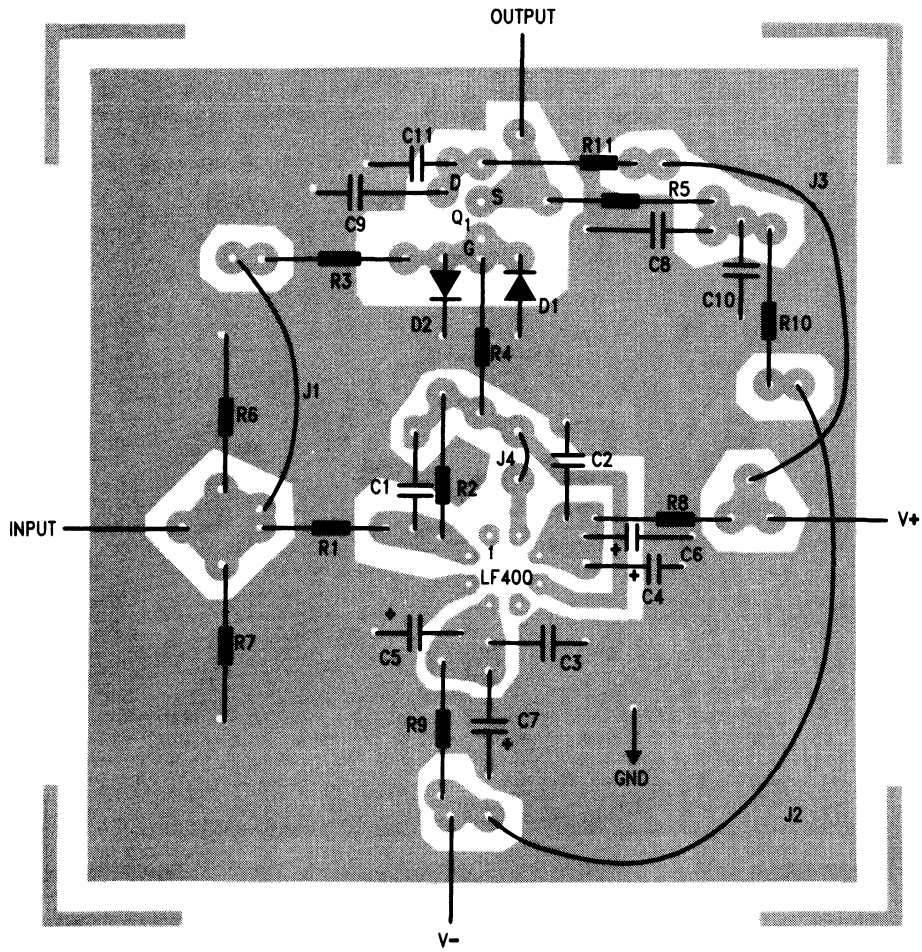


FIGURE 4b. Stuffing guide for LF400 settling time test board. Component side is shown.

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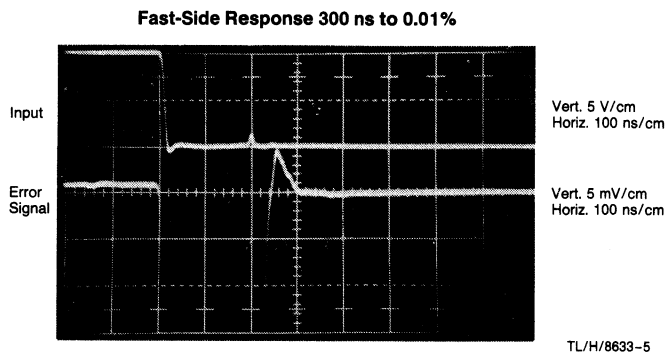
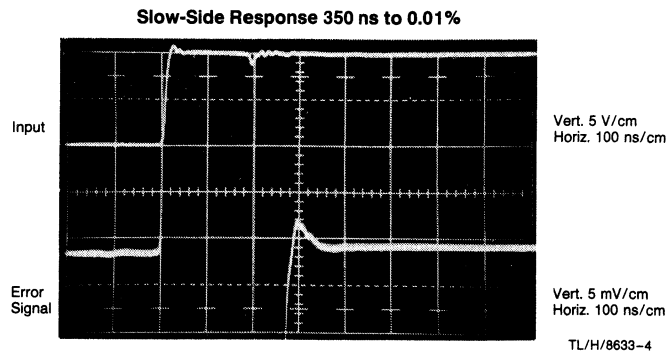


FIGURE 5. LF400 Settling Test Circuit Waveforms

Designing with the LMC835 Digital-Controlled Graphic Equalizer

National Semiconductor
Application Note 435
Mitchell Lee



INTRODUCTION

Because of the increasing use of digital techniques in consumer audio equipment, National has developed a digitally controlled graphic equalizer—the LMC835. This chip replaces the potentiometers used in a conventional graphic equalizer with digitally controlled step-variable resistors, thereby allowing computer manipulation of an analog signal path. The LMC835 is configured such that a high degree of flexibility remains in the overall equalizer design, without compromising the quality of the analog signal path.

Graphic equalizers are used to control the frequency response of an audio system. An equalizer contains a number of fixed-frequency bandpass/notch filters with a gain control for each filter. Resonances and nulls in the frequency response of an audio system are easily compensated with proper adjustment of the equalizer.

A single LMC835 contains enough step-variable resistors for a stereo, 7 band equalizer with 1 dB steps covering a ± 12 dB range. Up to 14 monaural bands can be accommodated by paralleling the two halves of the chip. Because the internal step-variable resistors are implemented with inherently well-matched SiChrome resistors, accurate 1 dB control steps are possible. The LMC835 is available in a plastic 28-pin dual-in-line package.

The digital sections of a finished equalizing instrument will include a microprocessor, pushbutton controls, a large, multisegment display and any necessary circuitry to drive the display. The analog sections will contain the LMC835 and a

number of associated operational amplifiers. Care has been taken in the design of the LMC835 to isolate sensitive analog circuitry from contamination by the digital sections. The analog sections of the equalizer will be considered first.

BASIC EQUALIZER TOPOLOGY

Many diverse equalizer circuit topologies have been commercially produced. A topology that works well within the constraints of step-variable resistors and uses a minimum of signal-path gain stages has been chosen for the LMC835.

The basic equalizer circuit shown in *Figure 1* uses two operational amplifiers in the signal path. This circuit represents $\frac{1}{2}$ of an LMC835. R_B , R_C , R_{V1} through R_{V7} , and the selector switches are included on-chip. The first amplifier provides the boost (bandpass) function, while the second amplifier buffers the cut (notch) function. For any one frequency band both boost and cut functions are possible, but they are never selected simultaneously. Redundant external analog circuitry is therefore eliminated by exclusively switching each tuned circuit to either boost or cut.

The amount of boost or cut is controlled by on-chip variable resistors R_{V1} through R_{V7} . These are designed to ratio with R_B and R_C for perfect 1 dB steps. An optional 6 dB control range with 0.5 dB steps is discussed later in this application note.

Step-variable resistors were chosen for the LMC835 since they lend themselves well to digital control. Each variable

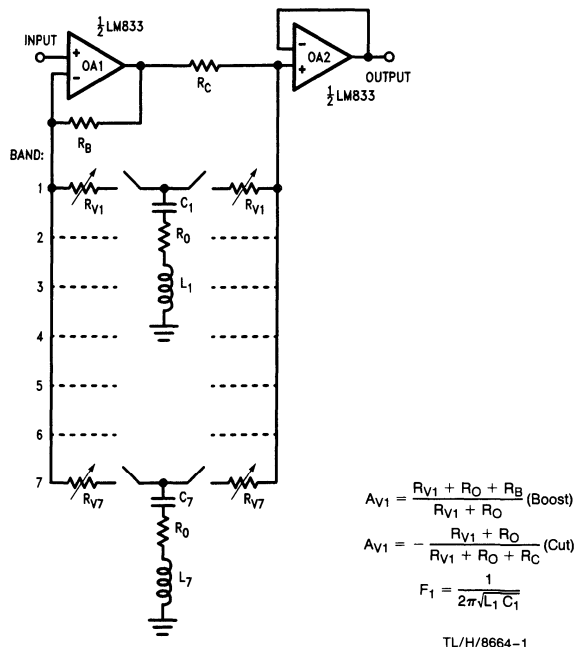
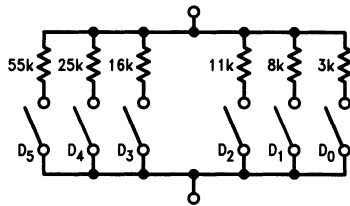


FIGURE 1. Basic Equalizer Topology

resistor shown in *Figure 1* is actually 6 fixed-value SiChrome resistors connected in parallel through CMOS FET switches. This is detailed in *Figure 2*. By selecting appropriate combinations of these 6 fixed resistors, better than 0.1 dB accuracy for each of 12 steps is obtained. The coding sequence is discussed in the programming section later.



TL/H/8664-2

LEVEL	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀
FLAT	0	0	0	0	0	0
1 dB	1	0	0	0	0	0
2	0	1	0	0	0	0
3	0	0	1	0	0	0
4	0	0	0	1	0	0
5	0	0	0	0	1	0
6	0	1	0	0	1	0
7	1	0	1	0	1	0
8	0	1	0	1	1	0
9	0	0	0	0	0	1
10	1	0	1	0	0	1
11	1	0	1	1	0	1
12	1	0	1	1	1	1

FIGURE 2. Digitally Controlled Variable Resistor

The frequency and bandwidth characteristics of each band are set by the L/C networks (*Figure 1*) and the value of each associated variable resistor. At resonance, the L/C network reduces to zero impedance. In the boost mode this leaves amplifier I with a gain set by the ratio of R_B and $R_O + R_V$. Conversely, attenuation is obtained in the cut mode with amplifier II buffering the circuit composed of R_C , R_O and R_V . Off resonance, the series tuned L/C network presents a high impedance and the gain (or attenuation) reduces to 1. Since the characteristics of the equalizer are determined by external L/C networks, the designer can tailor the equalizer circuit to suit his own needs.

Although it may seem that by relocating the switches of *Figure 1* a single bank of resistors could be used for boost and cut, this has not been done. Unlike mechanical switches, CMOS switches exhibit a finite ON resistance of several hundred ohms which unfortunately is not constant when large signal voltage swings occur across the switch. For a signal source with a nominal 1 Vrms level, with 12 dB

of boost selected the signal swing would produce unacceptable distortion. By locating the switches between the resistor banks and the resonant circuit the actual peak signal swing across the switch is reduced to well within a linear operating region of the switches. The complete circuit with a 1 kHz, 1 Vrms signal input exhibits less than 0.003% distortion even with 12 dB boost.

BAND FREQUENCY SELECTION

Two basic equalizer types are in common use: one type has fixed band frequencies, the second type has variable band frequencies that can be tuned to allow control at specific points. The first type (graphic equalizer) is by far the most common, and the second type (parametric equalizer) finds limited popularity owing its cost and difficulty of use. The LMC835 circuit topology described here is intended for fixed band frequency applications.

The selection of band frequencies is entirely independent of the LMC835 as the chip has no frequency-sensitive or frequency-determining characteristics. There are two basic methods for selecting frequencies: 1) spread the bands out evenly over some desired frequency range, or 2) space the bands closely over the range where more control is desired, and space them more widely elsewhere. An example of this second technique is *modified* spacing where bands are tightly spaced at the low frequencies to allow control where it is most useful. The few remaining bands are spaced more widely at the higher frequencies (> 500 Hz). Once the band frequencies have been selected, circuit Q, and the values for the series tuned circuits may be calculated. The following formulae find general use in equalizer design.

Band spacing is often measured in units of octaves. An octave covers a frequency ratio of 2:1, e.g. the frequencies between 1000 and 2000 Hz constitute an octave as do the frequencies between 200 Hz and 400 Hz. The number of octaves contained between any two frequencies is given by the equation

$$\# \text{ of octaves} = \text{LOG}(F_2/F_1)/\text{LOG}(2) \quad (1)$$

where $F_2 > F_1$. Another formula used in conjunction with equalizer design is that which finds the musical center between two frequencies:

$$\text{center frequency} = \sqrt{F_2 F_1} \quad (2)$$

As an example consider 2 frequencies, 220 Hz and 440 Hz. These are at an interval of 1 octave. At first glance it might appear that 330 Hz is halfway between these two, but as far as the ear can discern, 311 Hz is equidistant from 220 Hz and 440 Hz. This is because the ear hears logarithmic changes in pitch equally.

BAND SELECTION

In most consumer equalizers the band frequencies are equally spaced and centered around 1 kHz. The bands are related to each other by some factor. For example, 7-band equalizers with a 1 kHz center frequency use a factor of 2.5. If 1 kHz is repetitively multiplied and divided by 2.5 the other band frequencies will be found: multiplying (and rounding) we find 2.5 kHz, 6.3 kHz and 16 kHz, and dividing yields 400 Hz, 160 Hz and 63 Hz.

If the desired control range is defined, the center frequency can be found with the formula

$$\text{center band} = \sqrt{F_{\text{MAX}} F_{\text{MIN}}} \quad (3)$$

and the factor

$$\text{factor} = (F_{\text{MAX}}/F_{\text{MIN}})^{(1/d)} \quad (4)$$

F_{MIN} represents the lower -3 dB point of the "bottom" band when it is in full boost and all other bands are flat. F_{MAX} is the analogous higher -3 dB point of the "top" band. "d" is the number of bands. These formulae can be combined as

$$F_n = \left(F_{\text{MAX}} \frac{2n-1}{2d} \right) \left(F_{\text{MIN}} \frac{2(d-n)+1}{2d} \right) \quad (5)$$

where "n" is the band number (from 1 to d).

A common misconception about equalizers is that the band frequencies relate to the frequency response of the instrument. This is not true at all—the flat frequency response of the equalizer is completely independent of the band frequencies. Even so, many equalizer designs have bands extending beyond the normal range of hearing while compromising control at low frequencies.

There is no magic in spacing band frequencies. While equal spacing can offer control over a wide frequency range, it is possible to enhance control over a limited range by closely spacing the bands in one area while spreading out the remaining bands elsewhere. This technique (modified spacing) is especially useful at frequencies below 500 Hz where speakers and listening environments have pronounced resonances and antiresonances.

SELECTION OF MAXIMUM Q

The maximum desired Q of each band occurs at full boost or full cut and is set by the values of $R_O + R_V$, L_O and C_O . Mathematically Q_{MAX} is a function of the adjacent band frequencies:

$$Q_{\text{MAX}} = \frac{\sqrt{F_2}}{\sqrt{F_3} - \sqrt{F_1}} \quad (6)$$

where Q_{MAX} is the maximum Q of F_2 during full cut or boost, and F_3 and F_1 are the adjacent band frequencies. The highest and lowest bands on an equalizer have only one adjacent band. In this case:

$$Q_{\text{MAX}} = \text{ABS} \left(\frac{\sqrt{F_1 F_2}}{F_2 - F_1} \right) \quad (7)$$

where F_1 is the adjacent band. In terms of a factor:

$$Q_{\text{MAX}} = \frac{\sqrt{\text{factor}}}{\text{factor} - 1} \quad (8)$$

In terms of F_{MIN} and F_{MAX} :

$$Q_{\text{MAX}} = \frac{2d \sqrt{F_{\text{MAX}}/F_{\text{MIN}}}}{\sqrt{F_{\text{MAX}}/F_{\text{MIN}}} - 1} \quad (9)$$

The formulae for Q_{MAX} cause the -3 dB points of any two bands to occur at approximately the same frequency. If this is not desired, the maximum Q may be set to any value by appropriately designing the resonant networks. Higher values of Q give greater definition between bands while lower values of Q gives less ripple response between adjacent bands.

Once the maximum Q has been determined, L and C (from *Figure 1*) may be calculated:

$$L_n = 2270 Q_{\text{MAX}} / \omega_n \quad (10)$$

$$C_n = 1 / (\omega_n^2 L_n) \quad (11)$$

Note that 2270Ω is the minimum resistance including the 680Ω resistor (R_O), switch resistance and SiChrome resistance (R_V) as shown in *Figure 1*.

Using the typical 7-band consumer center frequencies (factor = 2.5) and a $Q_{\text{MAX}} = 1.05$ (from equation 8), the following values are calculated:

Band	Frequency (Hz)	L_O (mH)	C_O (nF)
1	63	6040	1060
2	160	2380	416
3	400	952	166
4	1000	381	66.5
5	2500	152	26.6
6	6300	60.4	10.6
7	16000	23.8	4.16

The inductances required at low frequencies would seem prohibitive, but there is an easy solution. The LMC835 is designed for use with series resonant networks. Since the inductances required are quite large and discrete realizations would be expensive, a simulated inductor, also called a gyrator, may be used.

GYRATOR DESIGN

The properties of an inductor may be simulated by a simple op amp circuit (often called gyrator) as shown in *Figure 3*. The impedance seen at the input terminal is $j\omega R_L R_O C_L$ and the inductance is given by the product $R_L R_O C_L$. As shown, R_O represents a loss resistance in series with the inductor. The internal SiChrome resistors are designed to accommodate an R_O of 680Ω .

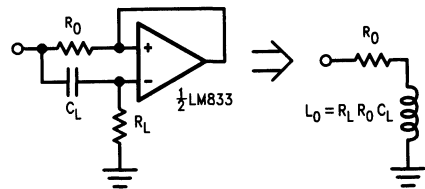


FIGURE 3. Simulated Inductor

TL/H/8664-3

At high frequencies the impedance of the gyrator should approach infinity, but several effects limit the maximum impedance. The result is an increase in high frequency gain as contributed by the boost section, and a decrease in high frequency gain as contributed by the cut section.

Gyrator impedance is ultimately limited by the loading effects of R_L , especially for smaller inductances since R_L necessarily becomes small. To reduce loading effects keep $R_L > 47 \text{ k}\Omega$. In extreme cases C_L and R_L can be buffered by a second op amp as shown in *Figure 4*.

The voltage divider action caused by stray capacitance at the junction of C_L and R_L also reduces gyrator impedance. This effect is minimized by keeping $C_L > 470 \text{ pF}$. Bootstrapping (*Figure 5*) is a viable alternative for reducing the effects of stray capacitance.

An important gyrator performance factor is the gain and phase of the op amp at high frequencies. An op-amp unity-gain bandwidth of at least 10 MHz is recommended since poor frequency response will reduce the gyrator impedance at high frequencies. Phase shift through the op amp causes the gyrator to become capacitive. The LM833 is an excellent choice for a gyrator as its bandwidth is well over 10 MHz, and it is unity gain stable.

Signal path stability and high frequency gain accuracy are affected by the feedback loop around the first amplifier of *Figure 6*. Most op amps cannot tolerate stray capacitance on their inverting input since it reduces the phase margin. This leads to increased gain at high frequency, if not insta-

bility. A 100 pF feedback capacitor compensates most op amps with little effect on the audio performance of the equalizer.

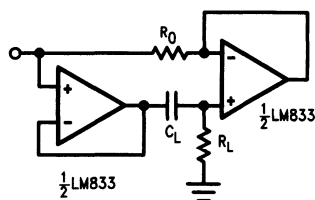


FIGURE 4. Buffered Gyrator

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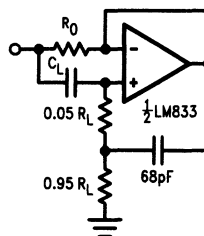


FIGURE 5. Bootstrapped Gyrator

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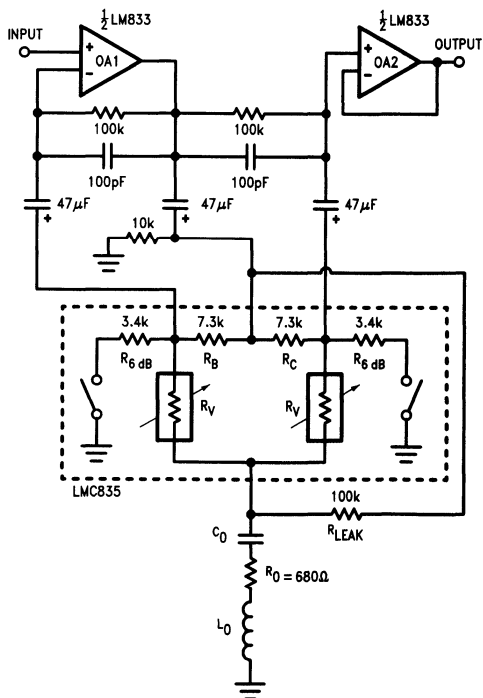


FIGURE 6. AC Coupled Signal Path

TL/H/8664-6

SWITCH LEAKAGE

When the CMOS switches are OFF, a small leakage current of typically 1 nA can flow either into or out of any of the gyrator connections. This current charges C_O until a state of equilibrium is reached. If one of the switches is now closed, the charge stored on C_O will be injected into the signal path possibly causing an audible "pop" in the output. A 100 k Ω resistor is all that is necessary (as shown in *Figure 6*) to bleed this charge away and prevent pops. This results in a gain error or less than 0.2 dB at maximum boost or cut.

Provision is made to convert the equalizer to a ± 6 dB control range. The 3.4 k Ω resistors shown in *Figure 6*, when selected, drop the control range to ± 6 dB with approximately 0.5 dB steps. When the 3.4 k Ω resistors are selected, the resultant changes in the signal path DC gain can produce pops. Op amp input offset voltage and bias current are the root cause; the solution is to AC couple the signal path to the LMC835. In addition to the three 47 μ F coupling capacitors of *Figure 6*, two 100 k Ω resistors are also neces-

sary to provide a DC path around the op amps. Since the majority of applications require a "popless" configuration, the internal 7.3 k Ω resistors have been adjusted to accommodate the effects of the external 100 k Ω resistors. If DC coupling is not used, the 100 k Ω signal path resistors should be included to insure gain accuracy.

A complete seven-band graphic equalizer circuit is shown in *Figure 7*. 470 Ω resistors are used in series with the output amplifiers to isolate capacitive loads that could cause instability. To increase signal handling capability the input is attenuated 6 dB by two 27 k Ω resistors and then equally amplified in the output buffer. With this configuration the maximum signal level at the input (with flat equalization) is about 9 Vrms yet the LMC835 sees only one-half of this—less than its ± 7.5 V supply limitation. Clipping is still possible if, for instance, a 9 Vrms input is boosted 12 dB. There is sufficient headroom to handle full boost on a 2 Vrms input signal. Gyrator component values are shown in *Figure 8*.

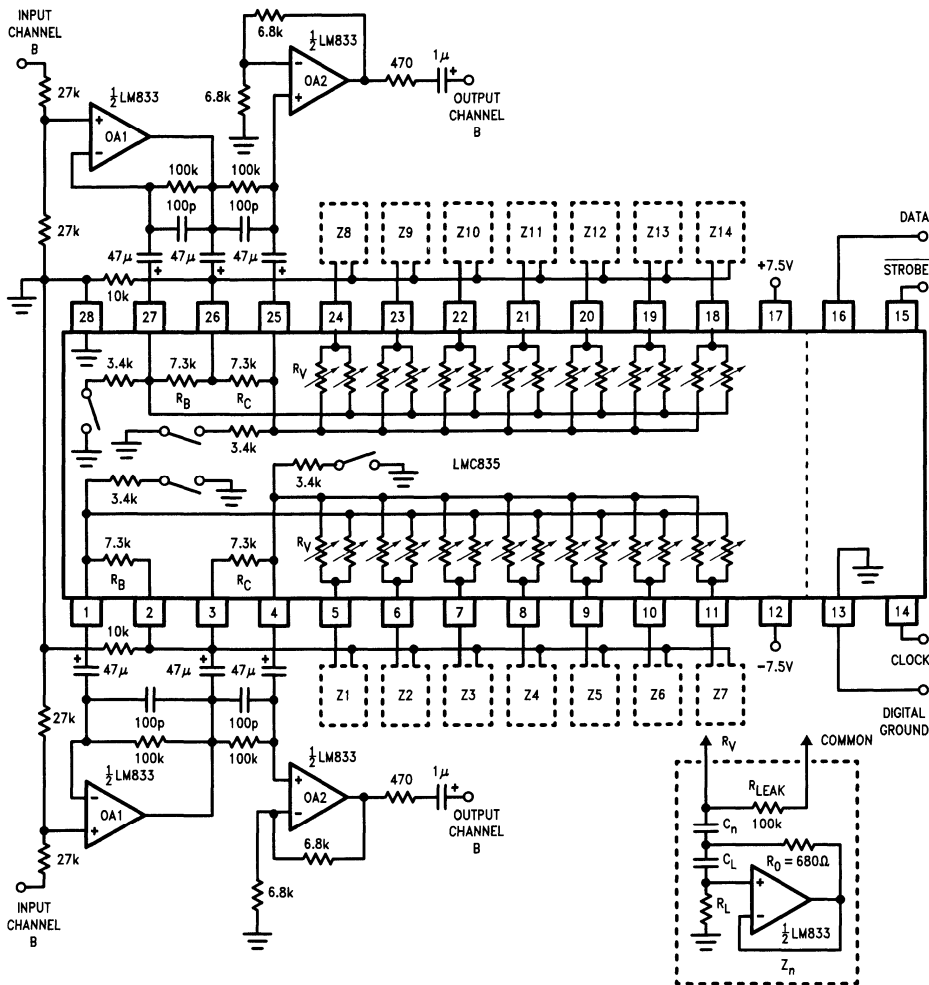


FIGURE 7. Complete 7-Band Graphic Equalizer

TL/H/8664-7

Z _n	f ₀ (Hz)	C _O (F)	C _L (F)	R _L (Ω)	R _O (Ω)
Z1, 8	63	1μ	100n	100k	680
Z2, 9	160	470n	33n	100k	680
Z3, 10	400	150n	15n	100k	680
Z4, 11	1k	68n	6.8n	82k	680
Z5, 12	2.5k	22n	3.3n	82k	680
Z6, 13	6.3k	10n	1.5n	62k	680
Z7, 14	16k	4.7n	680p	47k	680

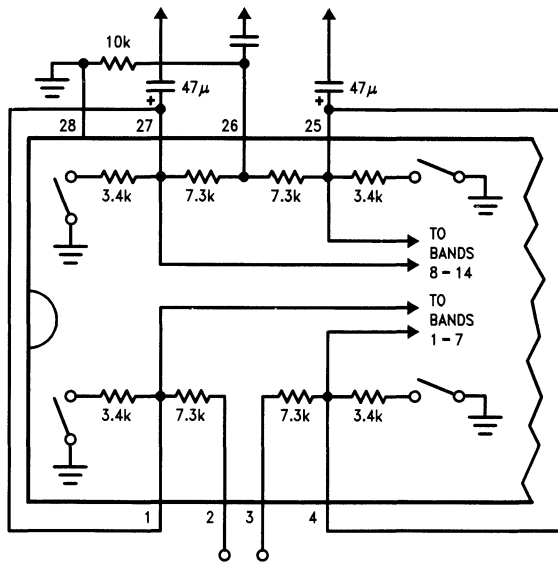
FIGURE 8. Gyrator Component Values

PARALLELING FOR MORE BANDS

The two halves of an LMC835 can be paralleled to provide up to 14 monaural bands. Paralleling (Figure 9) is accom-

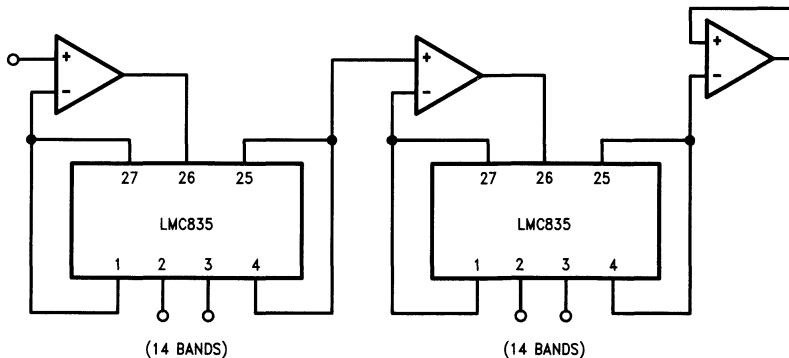
plished by connecting pin 1 to pin 27 and pin 4 to pin 25. Pins 2 and 3 are left open, and any unused gyrator pins are simply tied off to ground. The ±6 dB range is selected by activating only one set of ±6 dB resistors, and either set will do.

In applications requiring 15 to 28 bands a second LMC 835 can be cascaded as shown in Figure 10. Note that the output buffer of the first LMC835 is made redundant by the input amplifier of the second LMC835. Therefore only 3 signal path op amps are required instead of 4.



TL/H/8664-8

FIGURE 9. Paralleling for 8 to 14 Bands on One Chip



TL/H/8664-13

FIGURE 10

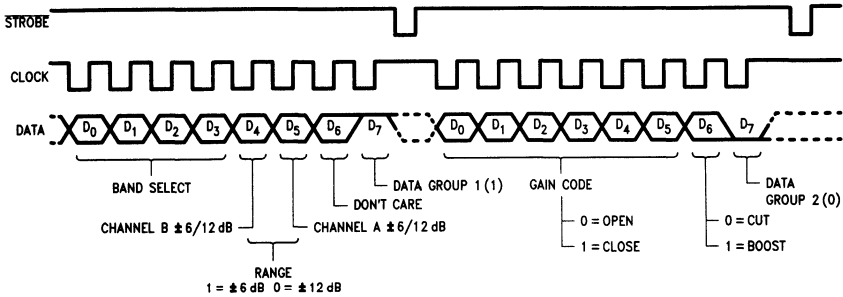
PROGRAMMING

A three wire interface consisting of a DATA, CLOCK and STROBE line (Figure 7) is provided for programming the LMC835. DATA bits are shifted in to an internal serial register on positive CLOCK edges. This data is then latched (and executed) by a low-going pulse on the STROBE pin. A separate digital ground pin is provided to prevent contamination of the sensitive analog signal path.

Programming is accomplished with two 8-bit words. The first word selects a band for adjustment and selects either of ± 6 or ± 12 dB control range. The second 8-bit word selects boost or cut and the desired level for the band previously

addressed. A timing diagram is shown in Figure 11. Note that bit D0 is shifted in first, D7 last. Figure 12 shows the coding used for band and gain selection. With the maximum clock rate of 500 kHz, the entire equalizer can be programmed in less than 500 μ s.

Parallel entry of data is possible using a simple word generator circuit as shown in Figure 13. A clock signal is applied continuously, and D0 through D7 are loaded and shifted into the LMC835 commencing with the positive edge of a start pulse. CLOCK, DATA and STROBE signals are all automatically generated and sequenced. D0 through D7 could be supplied by a parallel data bus or even toggle switches.



TL/H/8664-9

FIGURE 11. Timing Diagram

DATA I (BAND SELECTION)

D7	D6	D5	D4	D3	D2	D1	D0	
H	X	L	L	L	L	L	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, NO BAND SELECTION
H	X	L	L	L	L	L	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 1
H	X	L	L	L	L	H	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 2
H	X	L	L	L	L	H	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 3
H	X	L	L	L	H	L	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 4
H	X	L	L	L	H	H	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 5
H	X	L	L	L	H	H	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 6
H	X	L	L	L	H	L	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 7
H	X	L	L	H	L	L	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 8
H	X	L	L	H	L	L	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 9
H	X	L	L	H	L	H	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 10
H	X	L	L	H	L	H	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 11
H	X	L	L	H	H	L	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 12
H	X	L	L	H	H	L	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 13
H	X	L	L	H	H	H	L	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, BAND 14
H	X	L	L	H	H	H	H	CH A ± 12 dB RANGE, CH B ± 12 dB RANGE, NO BAND SELECTION
H	X	L	H					CH A ± 12 dB RANGE, CH B ± 6 dB RANGE, BAND 1~14
H	X	H						CH A ± 6 dB RANGE, CH B ± 12 dB RANGE, BAND 1~14
H	X	H						CH A ± 6 dB RANGE, CH B ± 6 dB RANGE, BAND 1~14

VALID BINARY INPUT

BAND CODE

CH B ± 6 dB/12 dB RANGE

CH A ± 6 dB/12 dB RANGE

DON'T CARE

DATA I

TL/H/8664-10

This is the gain if the ± 12 dB range is selected by DATA I. If the ± 6 dB range is selected, then the values shown must be approximately halved.

DATA II (BAND SELECTION)

	D7	D6	D5	D4	D3	D2	D1	D0
FLAT	L	X	L	L	L	L	L	L
1 dB BOOST	L	H	H	L	L	L	L	L
2 dB BOOST	L	H	L	H	L	L	L	L
3 dB BOOST	L	H	L	L	L	H	L	L
4 dB BOOST	L	H	L	L	L	H	L	L
5 dB BOOST	L	H	L	L	L	L	H	L
6 dB BOOST	L	H	L	H	L	L	H	L
7 dB BOOST	L	H	H	L	H	L	H	L
8 dB BOOST	L	H	L	H	L	H	H	L
9 dB BOOST	L	H	L	L	L	L	L	H
10 dB BOOST	L	H	H	L	H	L	L	H
11 dB BOOST	L	H	H	L	H	H	L	H
12 dB BOOST	L	H	H	L	H	H	H	H
1 dB~12 dB CUT	L	L						VALID ABOVE INPUT

BOOST/CUT

DATA II

GAIN CODE

TL/H/8664-11

FIGURE 12. Coding Information

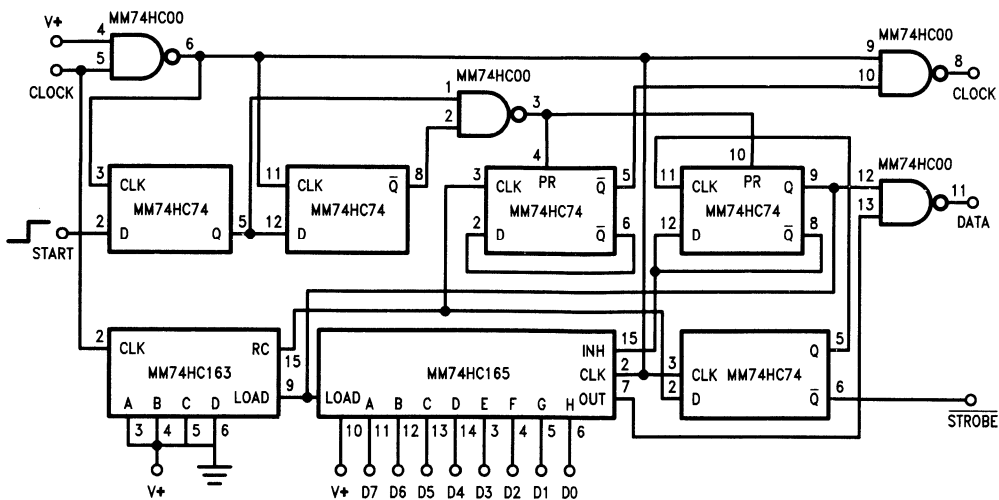


FIGURE 13. Test Word Generator

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APPLICATIONS

Several distinct advantages are associated with computer controlled equalizers. Remote control is possible unlike conventional mechanically controlled equalizers. Since the LMC835 is programmed by a simple 3-wire interface, hard-wired control from a remote location is also possible. This is useful on stage or in the studio where the equalizer must be located near the source and the amplifiers and/or speakers, but the control point is behind the audience or in a control room. The 3-wire digital interface is easier to connect than attempting to route low-level analog signal lines over long distances between signal source and control point.

Microprocessor storage of various equalization settings is possible. Specific settings for different instruments, diverse

program material, or perhaps multiple speaker or listening environments can be accessed as easily as recalling a pocket calculator memory. If a real time analyzer (RTA) is included in the equalizer, automatic equalization is possible. In this application pink noise is played through the amplifier/speaker system, and a calibrated microphone feeds the resultant spectrum back to the RTA. One band at a time, the controlling microprocessor adjusts the LMC835 equalizer for flat response. Two or three iterations are required since the adjustments are interactive.

By using analog circuit techniques, the LMC835 is able to achieve 0.0015% distortion, 114 dB signal to noise ratio and 20 dB headroom relative to a 1 Vrms input signal. This performance is suitable for use with conventional analog audio sources as well as digital audio formats.

A 150W IC Op Amp Simplifies Design of Power Circuits

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National Semiconductor
Application Note 446



Mineo Yamatake
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Abstract: A power op amp capable of driving $\pm 35V$ at $\pm 10A$ has been fabricated on a single silicon chip. Peak power ratings to 800W allow it to handle reactive loads. The IC incorporates internal management circuitry to insure smooth turn on and automatic protection from a variety of fault conditions; this includes instantaneous peak-temperature limiting within the power transistors. The op amp is described briefly, but emphasis is placed on the practical problems encountered in designing with power amplifiers. Numerous application examples are also given.

Introduction

Advances in IC technology have produced a power amplifier that is an order of magnitude more powerful than its predecessors. Unlike other IC's, its peak dissipation rating is many times higher than continuous, as is required for handling reactive loads. Protection circuitry is also more effective. The performance of the new IC, the LM12, puts it in the same class as discrete and hybrid amplifiers. However, it offers far more effective control of turn on, fault and overload conditions in addition to the economies of monolithic construction.

In the late 1960's, the availability of low cost IC op amps prompted their use in rather mundane applications, replacing a few discrete components. This power op amp now promises to extend this to high-power designs. Replacing single power transistors with an op amp may become cost-effective because of improved performance, simplification of attendant circuitry, vastly improved fault protection, greater reliability and the reduction in design time.

Some applications are given here to illustrate op amp design principles as they relate to power circuitry. Unusual design problems that have cropped up in using the LM12 in a wide variety of situations with all sorts of fault conditions are identified along with solutions.

the op amp

The performance of the LM12 is summarized in *Table I*. The input common-mode range extends to within a volt of the positive supply and to three volts above the negative supply. No input-polarity reversal is experienced should the input-voltage range be exceeded, and no damage results should the inputs be driven beyond the supplies.

The IC is compensated for unity-gain feedback, with a small-signal bandwidth of 700 kHz. Slew rate is $9V/\mu s$, even as a follower. This translates to a 60 kHz power bandwidth under load with a $\pm 35V$ output swing. The op amp is stable with or without capacitive loading; the maximum load capacitance depends upon loop gain. There are no spurious output stage oscillations, and a series-RC snubber is not required on the output.

The IC delivers $\pm 10A$ output current at any output voltage yet is completely protected against output overloads, includ-

ing shorts to the supplies. Dynamic safe-area protection is provided by peak-temperature limiting within the power transistor array. The turn-on characteristics are controlled by keeping the output open-circuited until the total supply voltage reaches 15V. The output is also opened should the case temperature exceed $150^{\circ}C$ or as the supply voltage approaches the BV_{CEO} of the output transistors. The IC withstands overvoltages to 100V.

The LM12 is supplied in a steel TO-3 package with four through leads, plus case. A gold-eutectic die attach to a molybdenum interface is used to avoid thermal fatigue problems with power cycling. Two voltage grades are available; both are specified for either the military or industrial temperature range.

Table I. Some typical characteristics of the LM12 for $V_s = \pm 40V$ and $T_C = 25^{\circ}C$.

parameter	conditions	value
input offset voltage	$V_{CM} = 0$	2 mV
input bias current	$V_{CM} = 0$	150 nA
voltage gain	$R_L = 4\Omega$	50V/mV
output voltage swing	$I_{OUT} = \pm 1.5A$	$\pm 38V$
	$\pm 10A$	$\pm 35V$
peak output current	$V_{OUT} = 0$	$\pm 13A$
	$T_C = 25^{\circ}C$	90W
continuous dc dissipation	$100^{\circ}C$	55W
	$t_{ON} = 10$ ms	120W
	1 ms	240W
pulse dissipation	0.2 ms	600W
	$R_L = 4\Omega$	150W
power output	$R_L = 4\Omega$	0.01%
total harmonic distortion	$A_V = 1$	700 kHz
bandwidth	$R_L = 4\Omega$	$9V/\mu s$
slew rate	$I_{OUT} = 0$	60 mA
supply current		

general advice

Power op amps are subject to many of the same problems experienced with general-purpose op amps. Excessive input or feedback resistance can cause a dc offset voltage on the output because of bias-current drops, or it can combine with stray capacitances to cause oscillations. Improper supply bypassing and capacitive loading, alone or in combination, can also result in oscillations. Many hours spent tracking down incomprehensible design problems could have been saved by monitoring the op amp output with a wide-band oscilloscope.

With low impedance loads and current transients above 10A, the inductance and resistance of wire interconnects can become important in a number of ways. Further, an IC op amp rated to dissipate 90W continuously will not do so unless it is properly mounted to an adequate heat sink.

The management and protection circuitry of the LM12 can also affect operation. Should the total supply voltage exceed ratings or drop below 15V, the op amp shuts off completely. Case temperatures above 150°C also cause complete shut down until the temperature drops to 145°C. This may take several seconds, depending on the thermal system. Activation of dynamic safe-area protection causes both the main feedback loop to lose control and a reduction in output drive current, with possible oscillations. In ac applications, the dynamic protection will cause waveform distortion.

supply bypassing

All op amps should have their supply leads bypassed with low-inductance capacitors having short leads and located close to the package terminals to avoid spurious oscillation problems. Power op amps require larger bypass capacitors. The LM12 is stable with good-quality electrolytic bypass capacitors greater than 20 μF . Other considerations may require larger capacitors.

The current in the supply leads is a rectified component of the load current. If adequate bypassing is not provided, this distorted signal can be fed back into internal circuitry. Low distortion at high frequencies requires that the supplies be bypassed with 470 μF or more, at the package terminals.

lead inductance

With ordinary op amps, lead-inductance problems are usually restricted to supply bypassing. Power op amps are also sensitive to inductance in the output lead, particularly with heavy capacitive loading. Feedback to the input should be taken directly from the output terminal, minimizing common inductance with the load. Sensing to a remote load must be accompanied by a high-frequency feedback path directly from the output terminal. Lead inductance can also cause voltage surges on the supplies. With long leads to the power source, energy stored in the lead inductance when the output is shorted can be dumped back into the supply bypass capacitors when the short is removed. The magnitude of this transient is reduced by increasing the size of the bypass capacitor near the IC. With 20 μF local bypass, these voltage surges are important only if the lead length exceeds a couple feet ($>1 \mu\text{H}$ lead inductance). Twisting together the supply and ground leads minimizes the effect.

ground loops

With fast, high-current circuitry, all sorts of problems can arise from improper grounding. In general, difficulties can be avoided by returning all grounds separately to a common point. Sometimes this is impractical. When compromising, special attention should be paid to the ground returns for the supply bypasses, load and input signal. Ground planes also help to provide proper grounding.

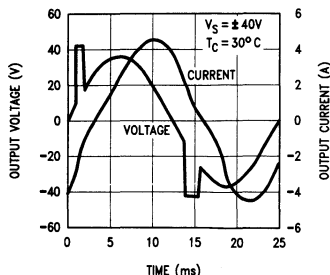
Many problems unrelated to system performance can be traced to the grounding of line-operated test equipment used for system checkout. Hidden paths are particularly difficult to sort out when several pieces of test equipment are used but can be minimized by using current probes or the new isolated oscilloscope preamplifiers. Eliminating any direct ground connection between the signal generator and the oscilloscope synchronization input solves one common problem.

output clamp diodes

When a push-pull amplifier goes into power limit while driving an inductive load, the energy stored in the inductance

can drive the output beyond the supplies. *Figure 1* shows the overload response of the LM12 driving $\pm 36\text{V}$ at 40 Hz into a 4Ω load in series with 24 mH to illustrate the point.

The IC has internal supply-clamp diodes, but these clamps have a parasitic current that dissipates roughly half the clamp current across the total supply voltage. This dissipation cannot be controlled by the internal protection circuitry and will result in catastrophic failure if sustained. Therefore, the use of external diodes to clamp the output to the power supplies is strongly recommended.

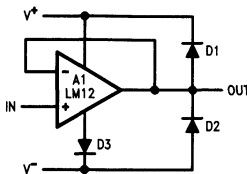


TL/H/8710-27

Figure 1. Output voltage and current waveforms with dynamic safe-area protection activated on an inductive load. Stored energy in the inductor drives the output beyond the supplies.

Experience has demonstrated that hard-wire shorting the output to the supplies can induce random failures if these external clamp diodes are not used. Therefore, it is prudent to use output clamp diodes even when the load is not obviously inductive. Failure is particularly violent when operating from low-impedance supplies: the V^+ pin can vaporize, with a hole being blown through the top of the can. If there are failures, install diodes before proceeding.

Heat sinking of the clamp diodes is usually unimportant in that they only clamp current transients. Forward drop with 15A transients is of greater concern. The clamp to the negative supply can have somewhat reduced effectiveness should the forward drop exceed 0.8V. Mounting this diode to the op amp heat sink improves the situation. Although the need has not been demonstrated, including a third diode, D_3 in *Figure 2*, will eliminate any concern about the clamp diodes. This diode, however, must be capable of dissipating continuous power as determined by the negative supply current of the op amp.



TL/H/8710-6

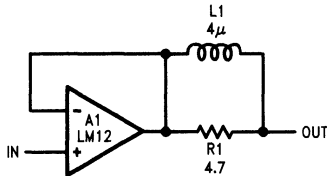
Figure 2. Output clamp diodes, D_1 and D_2 , dump inductive-load current into the supplies when op amp goes into power limit. A third diode, D_3 , may be required if the forward drop of D_2 is excessive.

reactive loading

The LM12 is normally stable with resistive, inductive or smaller capacitive loads. Larger capacitive loads interact with the open-loop output resistance (about 1Ω) to reduce the phase margin of the feedback loop, ultimately causing oscillation. The critical capacitance depends upon the feedback applied around the amplifier; a unity-gain follower can handle about $0.01\mu\text{F}$, while more than $1\mu\text{F}$ does not cause problems if the loop gain is ten. With loop gains greater than unity, a speedup capacitor across the feedback resistor will aid stability. In all cases, the op amp will behave predictably only if the supplies are properly bypassed, ground loops are controlled and high-frequency feedback is derived directly from the output terminal, as recommended earlier.

So-called capacitive loads are not always capacitive. A high-Q capacitor in combination with long leads can present a series-resonant load to the op amp. In practice, this is not usually a problem; but the situation should be kept in mind.

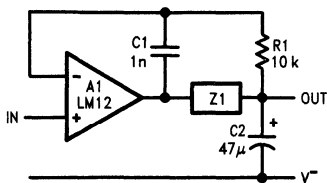
Large capacitive loads (including series-resonant) can be accommodated by isolating the feedback amplifier from the load as shown in *Figure 3*. The inductor gives low output impedance at lower frequencies while providing an isolating impedance at high frequencies. The resistor kills the Q of series resonant circuits formed by capacitive loads. A low inductance, carbon-composition resistor is recommended. Optimum values of L and R depend upon the feedback gain and expected nature of the load, but are not critical. A $4\mu\text{H}$ inductor is obtained with 14 turns of number 18 wire, close spaced, around a one-inch-diameter form.



TL/H/8710-7

Figure 3. Isolating capacitive loads with an inductor. The non-inductive resistor avoids resonance problems with load capacitance by dropping Q.

The LM12 can be made stable for all loads with a large capacitor on the output, as shown in *Figure 4*. This compensation gives the lowest possible closed-loop output impedance at high frequencies and the best load-transient response. It is appropriate for such applications as voltage regulators.



TL/H/8710-8

Figure 4. Using a large output capacitor to stabilize for all capacitive loads. The impedance, Z_1 , is the wire connecting the IC output to the load-capacitor terminal.

A feedback capacitor, C_1 , is connected directly to the output pin of the IC. The output capacitor, C_2 , is connected at the output terminal with relatively short leads. Single-point grounding to avoid dc and ac ground loops is advised.

The impedance, Z_1 , is the wire connecting the op amp output to the load capacitor. About 3 inches of number-18 wire (70 nH) gives good stability and 18-inches (400 nH) begins to degrade load-transient response. The minimum load capacitance is $47\mu\text{F}$, if a plastic film or solid-tantalum capacitor with an equivalent series resistant (ESR) of 0.1Ω is used. Electrolytic capacitors work as well, although capacitance may have to be increased to $200\mu\text{F}$ to bring ESR below 0.1Ω .

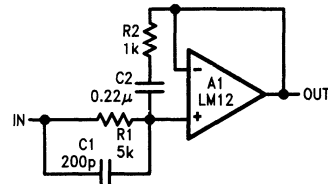
Loop stability is not the only concern when op amps are operated with reactive loads. With time-varying signals, power dissipation can also increase markedly. This is particularly true with the combination of capacitive loads and high-frequency excitation.

input compensation

The LM12 is prone to low-amplitude oscillation bursts coming out of saturation if the high-frequency loop gain is near unity. The voltage follower connection is most susceptible. This glitching can be eliminated at the expense of small-signal bandwidth using input compensation. Input compensation can also be used in combination with LR load isolation to improve capacitive load stability.

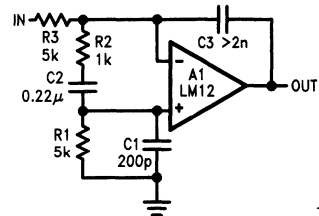
An example of a voltage follower with input compensation is shown in *Figure 5a*. The R_2C_2 combination across the input works with R_1 to reduce feedback at high frequencies without greatly affecting response below 100 kHz. A lead capacitor, C_1 , improves phase margin at the unity-gain crossover frequency. Proper operation requires that the output impedance of the circuitry driving the follower be well under $1\text{k}\Omega$ at frequencies up to a few hundred kilohertz.

Extending input compensation to the integrator connection is shown in *Figure 5b*. Both the follower and this integrator will handle $1\mu\text{F}$ capacitive loading without LR output isolation.



TL/H/8710-9

a) follower



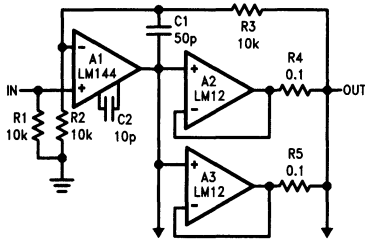
TL/H/8710-10

b) inverter

Figure 5. Using input compensation to reduce bandwidth and increase stability with capacitive loads a) for a voltage follower and b) for an integrating inverter.

parallel operation

Load current beyond the capability of one power amplifier can be obtained with parallel operation as shown in *Figure 6*. The power op amps, A_2 and A_3 are wired as followers and connected in parallel with the outputs coupled through equalization resistors, R_4 and R_5 . More output buffers, with individual equalization resistors, may be added to meet even higher drive requirements. A standard, high-voltage op amp is used to provide voltage gain. Overall feedback compensates for the voltage dropped across the equalization resistors.

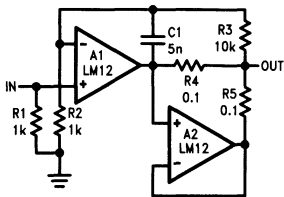


TL/H/8710-12

Figure 6. Paralleling the outputs of two op amps. The power amplifiers, A_2 and A_3 , are wired as followers and connected in parallel with the outputs coupled through equalization resistors.

With parallel operation there will be an increase in unloaded supply current related to the offset voltage of A_2 and A_3 across the equalization resistors. In some cases, it may be desirable to use input compensation on the followers for increased stability. It is important that the source resistance introduced by input compensation not increase the offset voltage overmuch.

A method of paralleling op amps that does not require a separate control amplifier is shown in *Figure 7*. The output buffer, A_2 , provides load current through R_5 equal to that supplied by the main amplifier, A_1 , through R_4 . Again, more output buffers can be added.



TL/H/8710-13

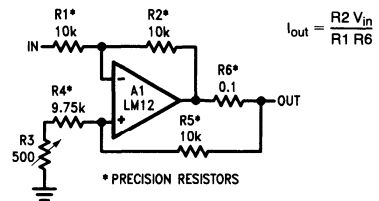
Figure 7. Two power op amps can be paralleled using this master/slave arrangement, but high frequency performance suffers.

The cross-supply current between the outputs of paralleled amplifiers can be affected by gain error as the power-bandwidth limit is approached. In the first circuit, the operating-current increase will depend upon the matching of the high-frequency characteristics. In the second circuit, however, the entire input error of A_2 appears across R_4 and R_5 . The supply current increase can cause the power limiting to be activated as the slew limit is approached. This will not damage the LM12. It can be avoided in both cases by connecting A_1 as an inverting amplifier and restricting bandwidth with C_1 .

current drive

The circuit in *Figure 8* provides an output current proportional to the input voltage. Current drive is sometimes preferred for servo motors because it aids in stabilizing servo loops by reducing phase lag caused by motor inductance. In applications requiring high output resistance, such as operational power supplies running in the current mode, matching of the feedback resistors to 0.01 percent or better is required. Alternately, an adjustable resistor, R_3 , can be used for trimming. Offsetting R_3 from its optimum value will give decreasing positive or negative output resistances.

The current source input is actually differential. It can be driven as shown, or from the bottom of R_3 to obtain the opposite output sense. Both inputs should be connected to a low source impedance like ground or an op amp output. Otherwise, the source resistance will imbalance the feedback, changing output resistance. Alternately, an input can be driven by a known source resistance, like a voltage divider, if this resistance is made part of the feedback network.



TL/H/8710-11

Figure 8. This voltage/current converter requires excellent resistor matching or trimming to get high output resistance. Bandwidth can be reduced by the inductance of R_6 .

The frequency characteristics of the current source can be expressed in terms of an equivalent output-load capacitance given by

$$C_{eq} = \frac{R_1 + R_2}{2\pi f_0 R_1 R_6} \quad (1)$$

where f_0 is the extrapolated unity gain bandwidth of the op amp (in this case about 2 MHz for the LM12). The equation is only valid for $Z_L \gg R_6$.

This output capacitance can resonate with inductive loads such as motors, causing some peaking. Inductive loads can oscillate should the feedback network be imbalanced to give sufficient negative output resistance.

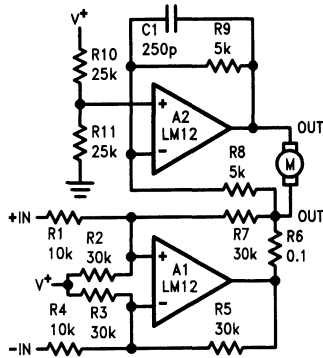
Inductance of the current sense resistor, R_6 , can affect operation. With a 0.1Ω resistor, $3\mu\text{H}$ series inductance will reduce the maximum obtainable bandwidth to 5 kHz. Proper supply bypassing and connecting R_2 directly to the output pin of the op amp are important with this circuit.

single-supply operation

Although op amps are usually operated from dual supplies, single-supply operation is practical. The bridged amplifier in *Figure 9* supplies bi-directional current drive to a servo motor while operating from a single positive supply. One op amp, A_1 , is a voltage/current converter with a differential input. The second is a unity-gain inverter driven from the output of the first. It has its non-inverting input referred to half the supply voltages so that the two outputs swing symmetrically about this voltage.

Either input may be grounded, with bi-directional drive provided to the other. It is also possible to connect one input to a positive reference, with the signal to the other input varying about this voltage. If this reference voltage is above 5V, R_2 and R_3 are not required.

The output is easily converted to voltage drive by shunting R_6 and connecting R_7 to the output of A_2 , rather than A_1 . Although not shown, clamp diodes to V^+ and ground on the output of both amplifiers are recommended for motor loads.



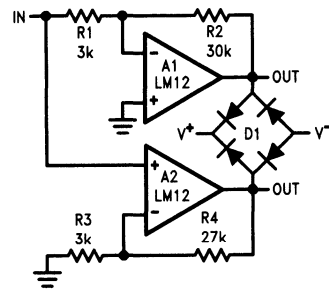
TL/H/8710-14

Figure 9. The output current of this bridged amplifier is proportional to differential input voltage. Although not shown, output clamp diodes are recommended with a motor load.

high voltage amplifiers

Using two amplifiers in a bridge connection also doubles the voltage swing delivered to the load. The configuration in *Figure 10* gives good results with split supplies. One op amp is an inverting amplifier while the other is a non-inverting amplifier with equal gain. A load connected between the outputs sees twice the swing of either amplifier. Understandably, the output slew rate doubles while the full-power bandwidth stays the same.

The current limit of two op amps cannot be expected to be the same. Therefore, a short between the outputs of a



TL/H/8710-15

Figure 10. Bridge connection gives differential output approaching twice the total supply voltage. Diode bridge clamps outputs to supplies.

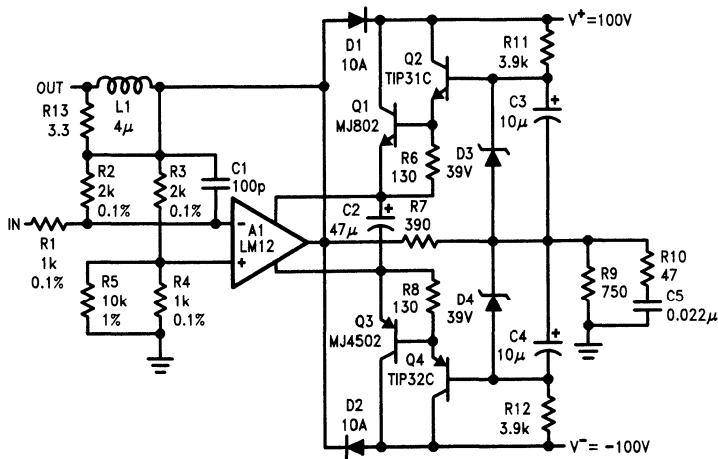
bridge amplifier can result in one amplifier saturating while the output transistor of the second handles the overload at the full supply voltage. Not all power amplifiers can take this kind of treatment; the LM12 will.

Figure 10 shows how a bridge-rectifier module can be used to provide output clamping for both outputs.

The LM12 can be operated in cascode with external transistors to get output swings several times higher than the basic op amp. The design in *Figure 11* drives $\pm 90V$ at $\pm 10A$. Significantly, the IC provides current and power limiting for the external transistors.

The transistors and zener diodes form a simple voltage regulator that is driven at 70 percent of the output swing from the R_7/R_9 divider. Thus, the total supply voltage of the IC stays constant while the voltage to ground swings some $\pm 60V$.

The supply terminals of the LM12 swing both above and below ground at full output. Therefore, the input terminals must be bootstrapped to the output to keep them within the common-mode range. The R_1-R_4 bridge does this. The bridge is unbalanced by R_5 to set the gain near 30. Naturally, R_4 and R_5 can be combined.



TL/H/8710-18

Figure 11. This amplifier can drive $\pm 90V$ at $\pm 10A$, more than twice the output swing of the LM12. The IC provides current and power limiting for the discrete transistors.

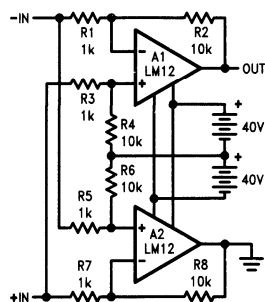
Bootstrapping the power supplies reduces the voltage swing across the internal frequency compensation capacitors of the LM12. The effectiveness of the capacitors is in proportion to the output swing across them. If the voltage swing between the output and V^- terminals of the IC is one-third the actual output swing, the slew rate and gain-bandwidth product of the complete amplifier will be three times that listed for the IC. The minimum loop gain must be increased accordingly.

Distortion on the bootstrapped supplies can show up on the output because the op amp has limited supply rejection at high frequencies. If R_6 and R_8 are not low enough, these power followers cannot track high frequency waveforms and performance will suffer.

This circuit is more sensitive to capacitive loading than the basic op amp because the supply terminals of the IC cannot be bypassed directly to ground. The effects of this can be mitigated by using an appropriate LR network in the output.

When the IC goes into power limit, current will likewise be cut back in the external transistors. The voltage on these external transistors is not necessarily regulated, so the discrete transistors must be enough stronger than the IC transistors to handle the extra voltage. The IC can handle orders of magnitude more power cycling than commercial power transistors with soft-solder die attach. Cycling in and out of power limit at low frequencies could be a problem and should not be ignored.

The output swing can be increased using more-conventional circuitry if floating supplies are available. *Figure 12* shows a bridged amplifier that drives a ground-referred load. A differential input is provided, but one input can be grounded and the other driven from a low-impedance source. If the non-inverting input is grounded, R_7 and R_8 can be replaced by a single resistor. Operation is like a standard bridge, except that it is a bit more sensitive to capacitive loading. Output swing is $\pm 70V$ at $\pm 10A$.



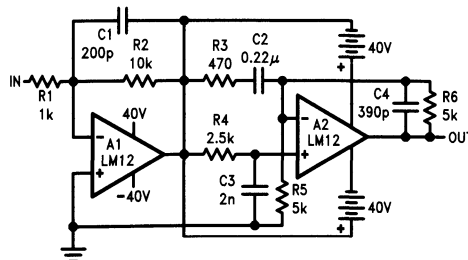
TL/H/8710-16

Figure 12. Bridge amplifier with a single-ended output uses floating supply. Either input can be grounded.

A final circuit in *Figure 13* shows how two op amps can be stacked to double output swing. A third op amp with a gain of 0.5 added to the output will triple the basic swing. Any number of op amps can be cascaded, adding to the swing, but a floating supply is required for each.

With two stages, clamp diodes from each amplifier output to its supply terminals are recommended. With three or more stages, the diodes are required to avoid supply reversals.

The bandwidth is limited by R_4 and C_3 . This isolation also prevents load transients on the output, reflected back to the



TL/H/8710-17

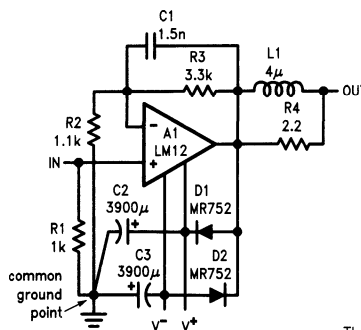
Figure 13. Cascading two op amps doubles output swing. Output may be increased by any number of stages, but a separate floating supply is required for each.

output of A_1 , from regenerating (this really shows up as capacitive load sensitivity). Like the other designs, an output LR will help reduce sensitivity to capacitive loading.

audio amplifiers

High quality audio amplifiers are wideband, power op amps with tight distortion specifications. The performance of the LM12 puts it in this class.

A practical design for an audio power amplifier is shown in *Figure 14*. Output-clamp diodes are mandatory because loudspeakers are inductive loads. Output LR isolation is also used because audio amplifiers are usually expected to handle up to $2 \mu F$ load capacitance. Large, supply-bypass capacitors located close to the IC are used so that the rectified load current in the supply leads does not get back into the amplifier, increasing high-frequency distortion. Single-point grounding for all internal leads plus the signal source and load is recommended to avoid ground loops that can increase distortion.

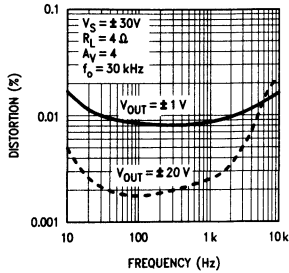


TL/H/8710-25

Figure 14. As an audio amplifier, the LM12 has better distortion, transient response and saturation recovery than most power op amps.

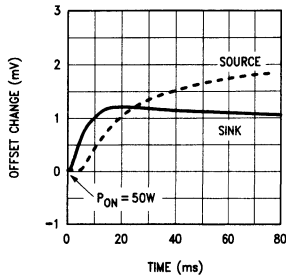
The total harmonic distortion measured for this circuit is plotted in *Figure 15*. The increase at high frequencies is due to crossover distortion of the class-B stage. That at low frequencies is caused by thermal feedback within the LM12.

The effect of thermal feedback on the response of the LM12 is indicated in *Figure 16*. The offset voltage change is plotted as a function of time after the application of an output load that dissipates 50W in the source and sink transistors.



TL/H/8710-30

Figure 15. Total harmonic distortion of the circuit in Figure 14 is plotted here for both low- and high-level outputs.



TL/H/8710-31

Figure 16. The offset voltage change after the application of a load that dissipates 50W in each output transistor is plotted here. This thermal feedback causes increased distortion below 100 Hz.

Unlike crossover distortion, the low-frequency distortion can be virtually eliminated by using the LM12 as a buffer inside the feedback loop of a low-level op amp. However, the low-frequency harmonic distortion, being generated thermally, is slow and does not cause the more objectionable intermodulation distortion. The latter measured 0.015 percent with $\pm 10\text{V}$ into a 4Ω load under the standard 60 Hz/7 kHz, 4:1 test conditions.

The transient response of the circuit in Figure 14 is clean; and saturation characteristics are glitch-free even at high frequencies. In addition, the $9\text{V}/\mu\text{s}$ slew rate of the LM12 virtually eliminates transient intermodulation distortion.

The availability of a low-cost power amplifier that is suitable as a high-quality audio amplifier can be expected to generate interest in using a separate amplifier to drive each speaker. Not only does this eliminate high-level crossover networks and attenuators, but also it prevents overloading at low frequencies from causing intermodulation distortion at high frequencies. With separate amplifiers, such clipping is far less noticeable.

servo amplifiers

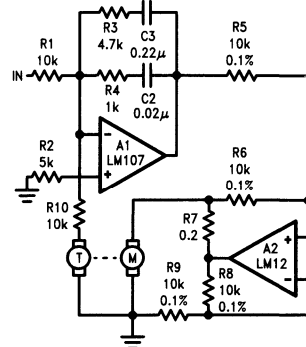
When making servo systems with a good power op amp, there is a temptation to use it for frequency shaping to stabilize the servo loop. Sometimes this works; other times there are better ways; and occasionally it just doesn't fly. Usually it's a matter of how quickly and to what accuracy the servo must stabilize. A couple of examples should make the point.

With fast motor-driven servos, it is best to make the motor current proportional to the servo amplifier drive. With current drive, motor response is basically unaffected by the series inductance of the motor windings. At higher frequencies, current drive can give 90 degrees less phase shift in the motor transfer function when compared to voltage drive. Should the servo loop go through unity gain at a frequency at which motor inductance is unimportant, the advantage of current drive is lost.

The motor/tachometer speed control shown in Figure 17 gives an example of optimizing performance using a current drive that is supplied by A_2 , connected as a voltage/current converter. The tachometer, on the same shaft as the dc motor, is simply a generator. It gives a dc output voltage proportional to the speed of the motor. A summing amplifier, A_1 , controls its output so that the tachometer voltage equals the input voltage, but of opposite sign.

With current drive to the motor, phase lag to the tachometer is 90 degrees, before second order effects come in. Compensation on A_1 is designed to give less than 90 degrees phase shift over the range of frequencies where the servo loop goes through unity gain. Should response time be of less concern, a power op amp could be substituted for A_1 to drive the motor directly. Lowering break frequencies of the compensation would, of course, be necessary.

The circuit in Figure 17 could also be used as a position servo. All that is needed is a voltage indicating the sense and magnitude of the motor shaft displacement from a desired position. This error signal is connected to the input, and the servo works to make it zero. The tachometer is still required to develop a phase-correcting rate signal because the error signal lags the motor drive by 180 degrees.



TL/H/8710-20

Figure 17. Motor/tachometer servo gives an output speed proportional to input voltage. Using current drive to motor reduces loop phase shift due to motor inductance.

The concept of a rate signal can be understood from a simple example. The problem is to rotate a radar antenna to acquire a target from a large angle off point. When the motor has limited power and the antenna has mass, the quickest path into point is to run full bore toward point; pick the correct instant to reverse at full power before getting there; and shut down in just the right place. In a servo, the rate signal added to the error signal is what tells it when to reverse in order to acquire the target without overshooting.

With a fixed target, a tachometer on the drive motor will give the rate signal. If the target is moving across the antenna, it does not: it produces the rate signal plus or minus the angular velocity of the target. This disrupts acquisition and generates a pointing error.

The rate signal can be obtained by differentiating the error signal. A design that gives the required error plus rate signal at the output is shown in *Figure 18a*. Neither op amp should saturate under any condition, no matter how far off point or how fast the error changes. If it saturates, a proper rate signal is not developed; and acquisition will be degraded. This can degenerate to where the servo will oscillate continuously once a certain tracking error is exceeded.

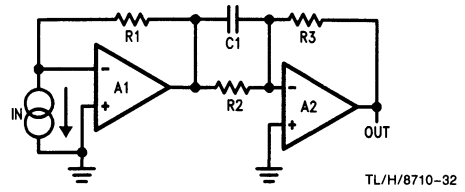
Acquiring from large errors quickly and to great accuracy requires an extremely wide dynamic range. In *Figure 18a*, it is necessary to make R_1 and R_3 so low to keep the amplifiers from saturating that chopper stabilization may be required to preserve accuracy.

In *Figure 18a*, R_3 can be raised to any value if back-to-back zeners are put across it. The waveform below the clamp level will be unchanged from the case where A_2 has unbounded output swing. Should the clamp levels be large enough to saturate the motor drive, operation is unimpaired.

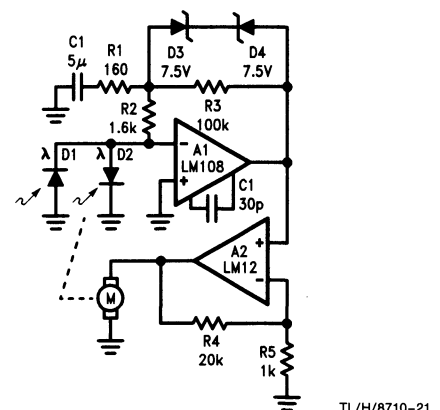
This principle is developed further in *Figure 18b*. It gives identical response, except that the resistor in series with C_1 breaks back the differentiator above the unity gain frequency. Off point, the voltage at the junction of R_1 and R_2 should not get so large that the output of A_1 cannot saturate A_2 without the clamps conducting.

operational power supply

External current limit can be provided for an op amp as shown in *Figure 19*. The positive and negative limiting currents can be set precisely and independently down to zero with potentiometers R_3 and R_7 . Alternately, the limit can be programmed from a voltage supplied to R_2 and R_6 . The input controls the output when not in current limit. This is just the set-up required for an operational power supply or voltage-programmable power source.

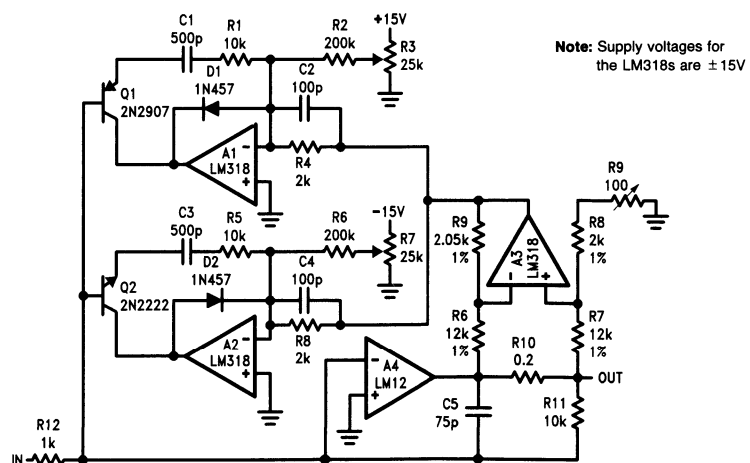


a) generating rate signal electrically



b) compressing dynamic range

Figure 18. When electrical rate signals must be developed with large error signals well beyond saturation of motor drive, a linear approach a) requires wide dynamic range and great precision. More practical design b) uses feedback clamps to increase effective dynamic range.



Note: Supply voltages for the LM318s are $\pm 15V$

Figure 19. Bi-directional limiting currents of the power op amp, A_4 , are set independently by R_3 and R_7 . Fast response is ensured by clamp diodes, D_1 and D_2 .

The power op amp, A_4 , is connected as an inverting amplifier. Its output current is sensed across R_{10} . This sense voltage is level shifted to ground by A_3 , a differential amplifier that is made insensitive to the op amp output level by trimming R_9 .

With current below preset levels, the outputs of A_1 and A_2 are clamped by D_1 and D_2 with Q_1 and Q_2 turned off. When the current threshold is reached, the relevant amplifier will come out of clamp, saturate the transistor on its output and take over control of the summing node. The clamp diodes limit the swing on the outputs of the current-control amplifiers while the transistors disconnect frequency compensation until the summing node is engaged. This ensures fast activation of current limit. Recovery back to voltage mode is also fast. The LM318 wideband amplifier is required for A_1 through A_3 .

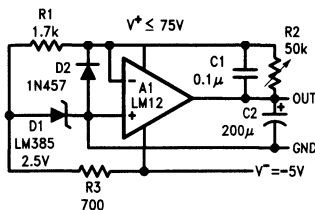
voltage regulators

An op amp can be used as a positive or negative regulator with equal ease. Unlike most dedicated voltage regulators, the output can both source or sink current to absorb energy dumped back into the supply and prevent overvoltage with certain fault conditions. Output transient response is also improved, especially overshoots.

A particular reason for using the LM12 as a regulator is its exceptional high-voltage capability. This not only gives output voltages to 70V, but also ensures startup under worst-case full-load conditions.

Compared to conventional IC regulators, using an op amp with an external reference has better accuracy: an optimum reference can be selected and thermally isolated from the power circuitry. Better regulation, temperature drift and long term stability result. Remote, output-voltage sensing at the load to further reduce errors is also practical.

A positive regulator with a 0–70V output range is shown in Figure 20. The op amp has one input at ground and a reference current drawn from its summing junction. With this arrangement, output voltage is proportional to the setting resistor, R_2 .



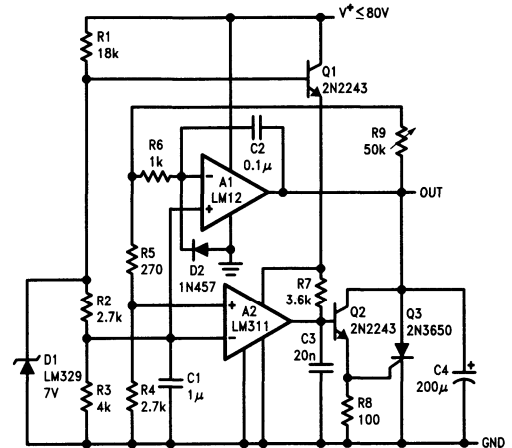
TL/H/8710-22

Figure 20. Positive regulator with 0–70V output range. Output will source or sink current, and start-up capability with higher input voltages is superior to standard IC regulators.

A negative supply is used to operate the op amp within its common-mode range, provide zero output with sink current and power a low-voltage bandgap reference, D_1 . Current drawn from this supply is under 150 mA, except when sinking load current.

The output load capacitor, C_2 , is part of the op amp frequency compensation. This requires that C_1 be connected directly at the op amp output and C_2 at the load, as described earlier. The reference noise is filtered by C_1 , which also controls the start-up rate. The clamp diode, D_2 , resets C_1 when the output is shorted and keeps the op amp input from being driven below V^- .

Dual supplies are not required to use an op amp for a regulator, as can be seen from the 4V to 70V adjustable regulator shown in Figure 21. This regulator also has overvoltage protection. Should an overvoltage condition exceed the current or power capabilities of the LM12, a comparator will trigger a SCR, crowbarbing the output.



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Figure 21. This 4V to 70V regulator operates from a single supply. Should the op amp not be able to control an overvoltage condition, the SCR will crowbar the output.

The reference is a low drift zener, D_1 , powered from V^+ through R_1 . The reference voltage is dropped to 4V and fed to the non-inverting input of the op amp, A_1 , with zener noise attenuated by C_1 . Thus, the output will be this 4V plus a voltage that is proportional to the resistance of R_6 . As before, D_2 is a clamp while C_2 makes sure the IC input is ac coupled directly to its output terminal.

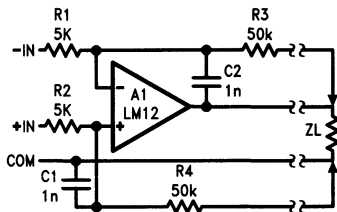
With overvoltage, a comparator, A_2 , fires the SCR through a buffer, Q_2 , after about a 20 μ s delay from C_3 to eliminate spurious transients. The comparator receives its power from Q_1 so that V^+ can be increased above the rating of the LM311.

Should the feedback terminal of the op amp rise more than 0.4V above the regulating value for longer than 20 μ s, the comparator will provide the signal required to fire the SCR. Since this can only happen if the considerable current and energy capabilities of the LM12 are exhausted, nuisance tripping is unlikely. The output trip threshold will be 0.4V above nominal as long as it happens quickly enough that the voltage across C_2 does not change appreciably. For a slow overvoltage condition, it is 10 percent above nominal.

remote sensing

With the current running at 10A, a foot of 0.1-inch-diameter copper drops 10 mV. Obviously, sizeable voltage drops will have to be accepted to run this kind of current over any distance without expensive and cumbersome cables.

Remote sensing, illustrated in Figure 22, can help the situation considerably. It uses a pair of small wires, in addition to the main power cables, to sense the voltage at the load. A feedback amplifier can then correct for the drop in the main cables.



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Figure 22. Remote sensing allows the op amp to correct for dc drops in cables connecting the load. Normally, common and one input are hooked together at the sending end.

The cables can cause delays in the feedback signal returning from the remote sense. This delay can make the feedback loop unstable unless the remote sense signal is ignored at higher frequencies. Thus, cable drop can be compensated but only at a limited rate; transient response suffers most. Heavy cables, closely spaced (or twisted) to minimize inductance, give fewest problems here.

The schematic in Figure 22 shows a differential-input amplifier that has dc feedback from the remotely-sensed load. The ac feedback is directly from the op amp output and the signal common at the sending end. There is no feedback from the load at high frequencies. The optimum capacitance depends upon the cable delay.

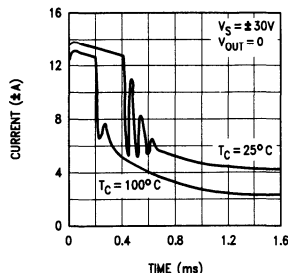
For single-ended input, the unused input terminal in the schematic would be strapped to the common. Feedback resistors should be reasonably matched to avoid second-order errors and the feedback resistors should be made enough greater than the sense line resistance to avoid gain errors.

Sometimes provision is made to control the circuit should the sense lines be disconnected. With a regulator, an imbalance current could be put into the sense lines to bring the regulator output to zero should one line go open. With bi-directional op amps, it is not obvious whether limiting the error with back-to-back diodes between the power-out and sense-in is better than having it go open loop.

power capabilities

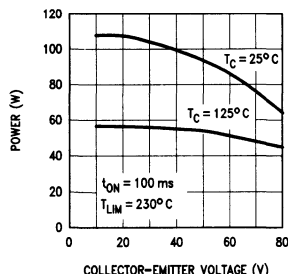
The output transistors of the LM12 will dissipate power until their peak junction temperature reaches 230°C ($\pm 15^\circ\text{C}$). When this temperature is reached, internal limiting circuitry takes over to regulate peak temperature. How this works is illustrated in Figure 23, which gives the peak output current waveform with the output instantaneously shorted to ground. Conventional current limiting holds the short-circuit current near 13A for a few hundred microseconds, then temperature limiting takes over as junction temperature tries to rise above 230°C. The response time of the temperature limiter is well under 100 μs .

With this type of protection, the power capabilities will depend on case temperature, transistor operating voltages and how the dissipation varies with time. Figure 24 shows the amplitude of a power pulse required to activate power limiting in 100 ms as a function of collector-emitter voltage on the output transistors for two case temperatures. The continuous dissipation limit is about 15 percent less than the 100 ms limit.



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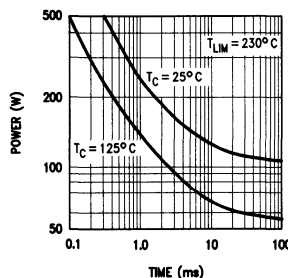
Figure 23. Output short-circuit current is reduced when power transistor junction temperature reaches 230°C and power limit takes over.



TL/H/8710-34

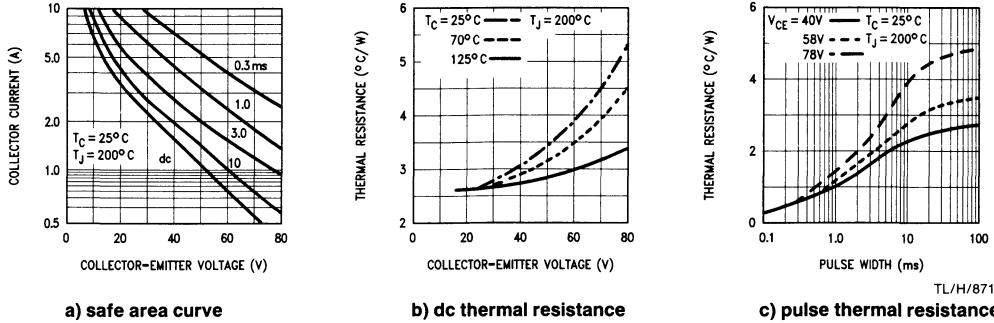
Figure 24. The power required to activate power limit is less at higher voltage, but this is not so pronounced at higher case temperatures.

The pulse capabilities of the output transistors are shown in Figure 25. The curves give the amplitude of a constant-power pulse required to activate power limiting in the indicated time. With pulse widths longer than 1 ms, the pulse capability decreases with collector voltages above 40V as indicated in Figure 24.



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Figure 25. The peak-dissipation capabilities of the power transistor are shown here. For times greater than 100 ms, the external heat sink will determine ratings.



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a) safe area curve b) dc thermal resistance c) pulse thermal resistance
Figure 26. The worst-case power ratings of the output transistors are described by a) a safe area curve, b) the change in dc thermal resistance with temperature and operating voltage and c) the pulse thermal resistance.

power ratings

The guaranteed power ratings of the LM12 are based on a peak junction temperature of 200°C rather than the 230°C limiting temperature. Test accuracy, guard bands and unit-to-unit variations are also taken into account. The result is that the guaranteed ratings are about 40 percent less than the power required to activate thermal limit.

The worst-case, safe-area curves for a peak junction temperature of 200°C with a 25°C case temperature are shown in Figure 26a. The guaranteed-maximum, dc thermal resistance is given as a function of collector-emitter voltage in Figure 26b. It can be seen from this figure that the increase in thermal resistance with voltage is much less at higher case temperatures. Finally, the equivalent thermal resistance for power pulses is given in Figure 26c. Again, these are worst-case numbers. The voltage dependency of thermal resistance in Figure 26c is for a 25°C case temperature. At higher case temperatures this dependency will be moderated as shown in Figure 26b.

The guaranteed power ratings are not established by statistical methods from sample tests. Instead, they are interpolated from actual measurements of power capability into thermal limit: these are standard production tests.

With ac loading, both power transistors share the dissipation; and the worst-case thermal resistance can drop to $1.9^\circ\text{C}/\text{W}$. However, it is necessary that the frequency be sufficiently high that the peak ratings of neither output transistor are exceeded.

thermal derating

It is not unusual to derate the maximum junction temperature of semiconductors below the manufacturer's specified value in worst-case design. The derating is often dictated by unpredictable operating conditions and design uncertainties. An equipment manufacturer does not want his product failing because of some obscure stress that is not apparent to the customer.

Company policies, equipment requirements and individual preferences vary as to what constitutes appropriate derating. When pressure is on for the best performance at lowest cost, a 200°C junction temperature for power semiconductors has been accepted, although this might well be influenced by whether hermetic or plastic packaging is used. Continuous operation at 200°C should also be treated differently than infrequent excursions to this temperature. Nonetheless, reducing temperature is a recognized method for increasing reliability; and ultra-reliable military and space applications have required that maximum junction temperatures be under 125°C .

The protection circuitry of the LM12 brings a new dimension to derating. Such conditions as out-of-spec line voltage or lack of air circulation cause the equipment to stop working temporarily; excessive stress or catastrophic failure does not result. It should be recognized, however, that there are certain applications where a temporary misfunction can be the same as a permanent one, definitely recommending derating.

Derating also reflects the user's faith in the ability of the manufacturer to adequately test the parts. Dynamic safe-area protection helps out here. Should a die-attach void or other defect produce hot spots in the power transistor, it will be rejected during production testing as having reduced dissipation capability, rather than being passed on as a reliability risk. This cannot be done with conventional power semiconductors.

No short-term failure mode has been found with modern IC power transistors even with peak junction temperatures of 300°C . However, power cycling can cause problems. Die-attach failures at 3×10^4 cycles with a 70°C temperature rise are possible with power transistors having a soft-solder die attach. The LM12 avoids this by using a gold-eutectic die attach to a molybdenum spacer. Even so, metalization failures have been experienced with the LM12 at 10^6 cycles from 50°C to power limit at 230°C with 200W dissipation.

Thermal derating is more applicable to the control circuitry of the LM12. Operating the control circuitry above 150°C can be expected to affect reliability. Fortunately, the control circuitry is exposed to only a fraction of the temperature rise in the power transistor. Derating may be based on a thermal resistance of $0.9^\circ\text{C}/\text{W}$ independent of operating voltage. With ac loading, where power is being dissipated in both power transistors, this thermal resistance drops, finally approaching $0.6^\circ\text{C}/\text{W}$.

package mounting

The ratings of the LM12 are based on the case temperature as measured on the bottom of the TO-3 package near the center. Proper mounting is required to minimize the thermal resistance between this region and the heat sink.

A good thermal compound such as Wakefield type 120 or Thermalloy Thermacote should be used when mounting the package directly to the heat sink. Without this compound, thermal resistance will be no better than $0.5^\circ\text{C}/\text{W}$, and possibly much worse. With the compound, thermal resistance will be $0.2^\circ\text{C}/\text{W}$ or less, assuming under 0.005-inch combined flatness run-out for the package and the heat sink. Proper torquing of the mounting bolts is important. Four to six inch-pounds is recommended.

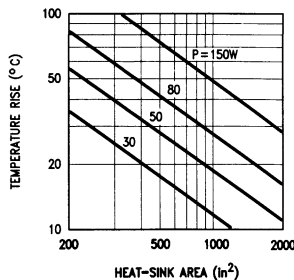
Should it be necessary to isolate V^- from the heat sink, an insulating washer is required. Hard washers like beryllium oxide, anodized aluminum and mica require the use of thermal compound on both faces. Two-mil mica washers are most common, giving about $0.4^\circ\text{C}/\text{W}$ interface resistance with the compound. Silicone-rubber washers are also available. A $0.5^\circ\text{C}/\text{W}$ thermal resistance is claimed without thermal compound. Experience has shown that these rubber washers deteriorate and must be replaced should the IC be dismounted.

heat sinking

With no heat sink, the internal temperature rise of the LM12 can be as high as 160°C with $\pm 40\text{V}$ supplies and no load. A heat sink is required. Heat sinks are commercially available, with data on their power rating and temperature rise supplied by the manufacturer. The types most suitable for dissipation in the order of 50W are made from extruded aluminum channel equipped with multiple fins. It is important that the heat sink have enough metal under the package to conduct heat from the center of the package bottom to the fins without excessive temperature drop.

The power rating of a multi-finned heat sink is determined largely by the surface area subject to convection cooling and the allowable temperature rise above ambient. Heat loss due to radiation can also be important with simple heat sinks. However, with multiple fins radiating toward each other, the significance of the radiation term drops. Nonetheless, heat sinks are usually black anodized to maximize radiation losses.

The surface area required for a given temperature rise and power dissipation can be estimated with fair accuracy from *Figure 27*. The area efficiency is affected by heat sink orientation, length and fin spacing. The figure assumes that the surfaces are located in a vertical plane. With the surfaces horizontal, temperature rise is increased by perhaps 20 percent. Vertical dimensions longer than 4 inches are less efficient. Commercial heat sinks are normally designed so that fin spacing is not so close as to affect the results of the figure.



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Figure 27. A heat sink is required to cool the IC package. This curve gives the rise in case temperature as a function of heat-sink fin area with convection cooling.

It is not possible to specify an unqualified thermal resistance for a convection or radiation cooled heat sink. Both mechanisms will give a lower thermal resistance with increasing temperature rise, while heat losses to radiation also increase with absolute temperature. Since radiation losses

are not dominant with multi-finned heat sinks, power dissipation and temperature rise should characterize performance. Heat sink size can be drastically reduced by forced air cooling, should it be available.

determining dissipation

It is a simple matter to establish the power that an op amp must dissipate when driving a resistive load at frequencies well below 10 Hz. Maximum dissipation occurs when the output is at one-half the supply voltage with high-line conditions. The individual output transistors must be able to handle this power continuously at the maximum expected case temperature.

If there is ripple on the supply bus, it is valid to use the average value in worst-case calculations as long as the peak rating of the power transistor is not exceeded at the ripple peak. With 120 Hz ripple, the peak rating is 1.5 times the continuous power rating.

Dissipation requirements are not so easily established with time-varying output signals, especially with reactive loads. Both peak- and continuous-dissipation ratings must be taken into account, and these depend on the signal waveform as well as load characteristics.

With a sine wave output, analysis is fairly straightforward. With supply voltages of $\pm V_S$, the maximum average power dissipation of both output transistors is

$$P_{\text{MAX}} = \frac{2V_S^2}{\pi^2 Z_L \cos \theta}, \quad \theta < 40^\circ; \quad (2)$$

and

$$P_{\text{MAX}} = \frac{V_S^2}{2Z_L} \left[\frac{4}{\pi} - \cos \theta \right], \quad \theta \geq 40^\circ, \quad (3)$$

where Z_L is the magnitude of the load impedance and θ its phase angle. Maximum average dissipation occurs for a peak output swing, E_P , given by

$$E_P = \frac{2V_S}{\pi \cos \theta}, \quad \cos \theta > \frac{2V_S}{\pi V_P}; \quad (4)$$

or

$$E_P = V_P, \quad \cos \theta \leq \frac{2V_S}{\pi V_P}; \quad (5)$$

where V_P is the maximum available output swing.

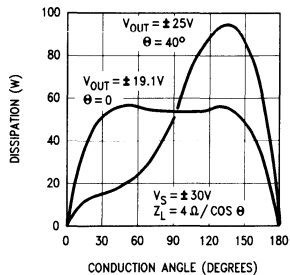
The instantaneous power dissipation is

$$P = \frac{E_P}{Z_L} \cos \omega t [V_S - E_P \cos(\omega t + \theta)]. \quad (6)$$

For $E_P = V_S$, the power peak occurs for $\omega t = \frac{1}{3}(\pi - \theta)$.

With practical amplifiers $E_P < V_S$, and a numerical solution is required.

The instantaneous power dissipation over the conducting half cycle of one output transistor is shown in *Figure 28*. Power dissipation is near zero on the other half cycle. The output level is that resulting in maximum peak and average dissipation. Plots are given for a resistive and a series R-L load. The latter is representative of a 4Ω loudspeaker operating below resonance and would be the worst-case condition in most audio applications. The peak dissipation of each transistor is about four times average. In ac applications, power capability is often limited by the peak ratings of the power transistor.



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Figure 28. Instantaneous power dissipation of one output transistor over its conducting half cycle with a resistive and an inductive load.

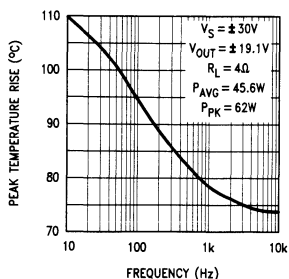
The pulse thermal resistance of the LM12 is specified for constant power-pulse duration. Establishing an exact equivalency between constant-power pulses and those encountered in practice is not easy. However, for sine waves, reasonable estimates can be made at any frequency by assuming a constant power pulse amplitude given by:

$$P_{PK} \cong \frac{V_S^2}{2Z_L} [1 - \cos(\phi - \theta)], \quad (7)$$

where $\phi = 60^\circ$ and θ is the absolute value of the phase angle of Z_L . Equivalent pulse width is $t_{ON} \cong 0.4\tau$ for $\theta = 0$ and $t_{ON} \cong 0.2\tau$ for $\theta > 20^\circ$, where τ is the period of the output waveform.

With the LM12, the peak junction-temperature rise for any given waveform can actually be measured. This is done by raising case temperature until power limiting is activated. Temperature rise is then computed from the measured case temperature based on a power-limit temperature of 230°C . Alternately, the power-limit temperature may be determined directly by measuring the dc dissipation at a collector-emitter voltage of 20V required to activate power limit. If this is done over a range of case temperatures, the results can be plotted and extrapolated to the power-limit temperature.

This procedure was used to give the peak temperature rise as a function of frequency for an op amp driving a resistive load under conditions of worst-case dissipation. The results are plotted in Figure 29.



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Figure 29. Peak junction-temperature rise as a function of frequency with an op amp driving a resistive load under conditions of worst-case dissipation.

dissipation driving motors

A motor with a locked rotor looks like an inductance in series with a resistance, for purposes of determining driver dissipation. With slow-response servos, the maximum signal amplitude at frequencies where motor inductance is significant can be so small that motor inductance does not have to be taken into account. If this is the case, the motor can be treated as a simple, resistive load as long as the rotor speed is low enough that the back emf is small by comparison to the supply voltage of the driver transistor.

A permanent-magnet motor can build up a back emf that is equal to the output swing of the op amp driving it. Reversing this motor from full speed requires the output drive transistor to operate, initially, along a loadline based upon the motor resistance and total supply voltage. Worst case, this loadline will have to be within the continuous dissipation rating of the drive transistor; but system dynamics may permit taking advantage of the higher pulse ratings. Motor inductance can cause added stress if system response is fast.

Shunt-and series-wound motors can generate back emfs that are considerably more than the total supply voltage, resulting in even higher peak dissipation than a permanent-magnet motor having the same locked-rotor resistance.

voltage regulator dissipation

The pass transistor dissipation of a voltage regulator is easily determined in the operating mode. Maximum continuous dissipation occurs with high line voltage and maximum load current. As discussed earlier, ripple voltage can be averaged if peak ratings are not exceeded; however, a higher average voltage will be required to ensure that the pass transistor does not saturate at the ripple minimum.

Conditions during start-up can be more complex. If the input voltage increases slowly such that the regulator does not go into current limit charging output capacitance, there are no problems. If not, load capacitance and load characteristics must be taken into account. This is also the case if automatic restart is required in recovering from overloads.

Automatic restart or start-up with fast-rising input voltages cannot be guaranteed unless the continuous dissipation rating of the pass transistor is adequate to supply the load current continuously at all voltages below the regulated output voltage. In this regard, the LM12 performs much better than IC regulators using foldback current limit, especially with high-line input voltages above 20V.

power supplies

Power op amps do not require regulated supplies. However, the worst-case output power is determined by the low-line supply voltage in the ripple trough. The worst-case power dissipation is established by the average supply voltage with high-line conditions. The loss in power output that can be guaranteed is the square of the ratio of these two voltages. Relatively simple off-line switching power supplies can provide voltage conversion, line isolation and 5-percent regulation while reducing size and weight. The regulation against ripple and line variations may provide a substantial increase in the power output that can be guaranteed under worst-case conditions. In addition, switching power supplies can convert low-voltage power sources such as automotive batteries up to regulated, dual, high-voltage supplies optimized for powering power op amps.

checking thermal design

Thermal design margins can be established by determining how far the part can be pushed beyond nominal worst-case before power limiting is activated. This extra stress can be applied by increasing case temperature, supply voltage or output loading.

Raising case temperature with worst-case electrical conditions has the advantage of giving results that are easily interpreted in terms of thermal design margins. If the case temperature, as measured at the center of the package bottom, must be raised 50°C above the maximum design value to activate power limiting, the worst-case, peak-junction temperature is 180°C, or 50°C below the power-limit temperature.

With this technique, it is important that the case temperature be kept below 140°C. At 150°C, the case-temperature limit activates, shutting the IC down completely.

conclusions

A new concept for power limiting and advances in IC design have been combined to produce a monolithic, high-power

op amp that challenges the best hybrid and discrete designs. Impressive power ratings are obtained along with better control of fault conditions. The part is easy to use, quite tolerant of abuse and has few disagreeable characteristics.

Design problems peculiar to power op amps have been discussed. They present no serious difficulty if kept in mind. Methods of increasing output capabilities beyond those of the basic part were also shown to demonstrate its flexibility. A number of conventional applications for power op amps were detailed along with others that would not normally use an op amp. It is expected that this power IC will recommend itself for a wide range of currently obscure, general-purpose applications.

One of the more onerous tasks with power devices is establishing that a design operates components within ratings. Guidelines were given for determining continuous and transient dissipation. In addition, the basic problems of providing adequate heat sinking were outlined. Dynamic safe-area protection is of particular help here in that design margins can actually be measured, rather than inferred from published data.

Protection Schemes for BI-FET™ Amplifiers and Switches

National Semiconductor
Application Note 447
Wanda Garrett



To use integrated circuits in real applications, designers must know the limitations of the devices. The majority of the limitations are published in the datasheets, and these fall into two categories: Absolute Maximums—which, if violated, can cause damage or destruction of the device; and Electrical Characteristics—which indicate the performance limitations. Unfortunately, these specifications don't explain the consequences of a violation, nor what may happen between the violation of an Electrical Characteristic limit and an Abs. Max. limit. This information is needed so the designer can design an appropriate protection scheme.

This article will focus on National Semiconductor Corp. BI-FET op amps: how to improve their reliability and performance. In most cases, the results are similar for bipolar op amps also.

THE BI-FET FAMILIES

Our BI-FET op amps are divided into four families: LF411, LF441, LF356, and LF400. The LF411 family consists of LF411, LF351, and TL081 (all singles); LF412, LF353, and TL082 (duals); and LF347 (quad). This is a good general purpose set of op amps that all have the same internal design, differing only by grade.

The LF441 family consists of the LF441 (single), LF442 (dual), and LF444 (quad). This family gives nearly the same DC performance as the LF411's for 1/12th the supply current. However, because they are low-power devices, they are also proportionally slower than the 411's.

The LF356 family includes the LF355, LF356, and LF357 (in the commercial temperature range). The 355 is the low- I_{CC} part, and the 357 is the wide-bandwidth part. All of the family have good DC specs and can drive a lot of capacitance (to .01 μF , typically). They are also among our faster op amps, having slew rates which vary from 5V/ μs (for the 355) to 50V/ μs (for the 357).

The LF400 and LF401 are fast-settling amplifiers whose input stages closely resembles the LF356's, and so require similar input protection. However, their output stages are more delicate than the 356's in that they cannot drive much capacitive load (on the order of 50 pF).

The operating restrictions for these families are nearly all the same, as are the methods of protection. In some cases (as will be pointed out) certain families are better at surviving the abuses than others. In addition, the BI-FET switches (LF13508, LF13509, and the LF13333 family) require similar protection schemes.

EXCEEDING COMMON-MODE INPUT VOLTAGE RANGE

Our BI-FET Applications Hints describe the consequences of exceeding the common-mode limits while remaining inside the supply voltages: "Exceeding the negative common-mode limit on either input will cause a reversal of the phase to the output and force the amplifier output to the corresponding high or low state. Exceeding the negative common-mode limit on both inputs will force the amplifier output to a high state. In neither case does a latch occur since

raising the input back within the common-mode range again puts the input stage and thus the amplifier in a normal operating mode.

"Exceeding the positive common-mode limit on a single input will not change the phase of the output; however, if both inputs exceed the limit, the output of the amplifier will be forced to a high state.

"The amplifiers will operate with a common-mode input voltage equal to the positive supply; however, the gain bandwidth and slew rate may be decreased in this condition. When the input common-mode voltage swings to within 3V of the negative supply, an increase in input offset voltage may occur."

In the first case, when the + input goes below the negative common-mode limit, a diode formed by the p-type FET channel and the n-type gate begins to conduct. This steals current from the input stage's current source, depriving the + input FET of a lot of its I_{DS} current. This gives the effect of a large differential input of the opposite polarity (i.e. an "increase in input offset voltage"), and causes the output to head to the positive rail (i.e. changes phase).

If the - input, or both inputs, goes below the negative common-mode limit, the input voltage to the second gain stage gets so low the second stage turns off. However, its current source is still running, so the current gets shunted to the output stage and forces it high.

In the second case, if both inputs rise too high, the input stage current source becomes shut off. The second stage input is again forced low and the output stage is forced high.

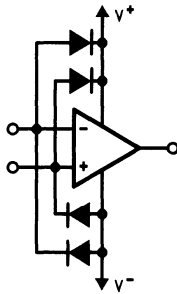
INPUTS EXCEEDING SUPPLY RAILS

If either input is pulled above V^+ , nothing happens until the difference between the input and V^+ gets near the breakdown voltage, typically 50V. At this point, the FET's gate-source junction avalanches and will draw all the current it can. Limiting this input current to something less than 3 mA helps prevent damage. The best protection (in addition to limiting the input current) is a diode clamp from each input to V^+ . If transients are expected, use a fast-recovery diode, such as an IN4148. For low-leakage (but less speed), the C-B junction of a good transistor (i.e. 2N3904) is recommended.

Failure to clamp the voltage or limit the current adequately may not destroy the part, but the offset voltage and bias current will be permanently degraded.

If either input is pulled more than a few tenths of a Volt below V^- (even if this pin is floating), a lightly-doped parasitic substrate transistor turns on. This transistor's collector current cannot be controlled externally, so allowing it to turn on can cause metal migration and destruction of the input stage (or at least a major unbalancing). In the newer LF411, LF441 and LF400 families, this transistor has been controlled by the addition of a diode from base to emitter which kills the gain of the transistor and keeps its current low. However, the older parts and members of the LF356 family are still susceptible, so it is best to protect all the BI-FETS

from this potential abuse by using the clamp diodes (see *Figure 1* below).



TL/H/8744-1

FIGURE 1. Clamping Inputs of Op Amp

Since this parasitic transistor turns on easily, the best way to keep it turned off is to use a Schottky diode, its on-voltage being less than that required to turn on the transistor. For lower leakage, a short-base switching diode (such as the Fairchild FD200 series) may be used. Its forward drop will be larger at low currents, but will stay constant for a wide current range, as opposed to the relatively leaky Schottky diodes.

POWER SUPPLY SEQUENCING

Adding the clamp diodes shown in *Figure 1* not only protects the inputs from transients when the circuit is operating, but protects them as power is being applied to the circuit. Because the parasitic transistor appears when the input voltage is less than the negative supply, applying the positive supply or input voltage before the negative supply is applied can cause this problem. For this reason, it is always recommended that the negative supply be turned on **first**, if the supplies can be turned on independently. This is especially important for protection of the BI-FET switches.

Also, even if the input stage is well protected with clamp diodes and current limiting, the inputs should not be allowed to be heavily unbalanced (for example, one input at ground and the other at the rail) for extended periods of time (for example, many hours). The long-term effects of an unbalanced differential pair are increased offset voltage and offset current.

SUPPLY VOLTAGES OUT OF RECOMMENDED RANGE

Attempting to run a BI-FET on supply voltages less than the recommended total of 10V will narrow the common-mode input and output ranges, and slow the part down. In the LF411 family, at supply voltages less than 7V, an internal biasing zener turns off and the entire part quits working. With the LF441 family, a supply voltage of less than 6V is not enough to support the internal current source biasing, so eventually these also turn off. And the LF356 family needs all of the 10V to stay in operation.

Running the BI-FETs on supply voltages greater than the Abs. Max limit generally does no harm until the parasitic diode from $V+$ to the substrate breaks down (in LV_{ce0}) or the input gate-source junction breaks down (BV_{gso}). Limiting the supply current to something less than 10 mA improves the chances of the op amp's survival. These breakdowns typically occur at about 50V, but the devices are only tested up to 36V or 40V, depending on the device. In addition, power dissipation must be considered when the supply voltage is large.

OPERATING TEMPERATURE OUT OF ABSMAX RANGE

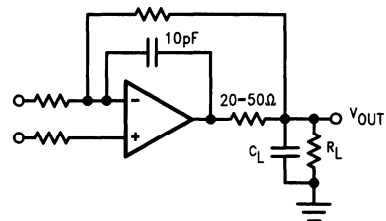
BI-FETs generally operate well when the ambient temperature is cold. The bias current becomes minimal, the input noise often decreases, and the bandwidth increases. However, if the device is in a marginally stable design, it may oscillate as its phase margin will also decrease.

Conversely, running the BI-FETs at temperatures greater than 100°C brings the bias current into the nanoamp range, and drops the gain-bandwidth product by 20% or more (compared to 25°C performance). Most op amps quit working between 180°C and 250°C due to excessive leakage currents or internal thermal shutdown mechanisms, and the BI-FETs are no exception. The maximum guaranteed junction (die) temperature of our ICs is 150°C, and some lower-grade parts and those in plastic DIP packages are guaranteed to as low as 100°C.

The type of package used affects the maximum ambient temperature allowed, since the junction temperature must remain in the "legal" range and the different packages have different heat-sinking properties. The metal can packages have the lowest thermal resistance, and have the additional advantage that heat-sink fins are easy to find and attach to the package (when needed).

DRIVING CAPACITANCE

Both the LF411 and LF441 families have a lot of trouble driving more than about 200 pF without oscillating. And being built for precision settling rather than power, the LF400 and LF401 can barely drive more than 50 pF. Standard techniques to get around this problem are to add a small resistor (about 50Ω) in series with the output (see *Figure 2*) or to use one of the LF356 family (the 356 itself being the most popular for this purpose). An explanation of why the 356 output stage is so unusually strong is provided in the second reference listed.



TL/H/8744-2

FIGURE 2. Isolating a Capacitive Load

When extra output filtering is desired, a series RC damper will often be more effective than just a large filter capacitor.

POWER SUPPLY BYPASSING

Another potential cause of oscillation is inadequate power supply bypassing.

In addition to the familiar problem of noise added through the supply inputs (due to poor high-frequency rejection), the inductance of the power supply leads degrades the effectiveness of the op amp's internal compensation, which invites oscillation.

The BI-FETs need the supply bypassing most on their $V-$ terminals, as do many of the bipolar-input amplifiers. Good bypassing techniques include (1) putting the bypass capacitors right next to the IC, and (2) using an appropriate type and size of capacitor. Ceramic types are often used because of their small size and low cost, but their effective-

ness is limited to about 1 MHz. Typical values used are between $0.01 \mu\text{F}$ and $0.47 \mu\text{F}$.

Tantalum capacitors are often used for high-frequency bypassing. However, their lead inductance can sometimes aggravate the situation instead of correcting it. Adding a small ($0.01 \mu\text{F}$) ceramic disc capacitor in parallel with the tantalum improves the overall performance. Typical values used for tantalum bypass capacitors range from $2.2 \mu\text{F}$ to $10 \mu\text{F}$.

Mylar capacitors are also used for bypassing, but the monolithic ceramics have better high frequency performance and cost less.

Where the supply voltages have poor load regulation, electrolytic capacitors (typically $10 \mu\text{F}$ to $47 \mu\text{F}$) can provide additional filtering.

DEALING WITH THE OFFSET VOLTAGE

If the offset voltage of a BI-FET op amp is first measured in a test circuit, and then again after the device is installed in the final circuit, a change in V_{OS} will often be detected. This is due to a difference in stress put on the die when the device (packaged or not) is installed in the two circuits. Because the input JFETs are largely surface devices, any stress on them changes their characteristics noticeably. This, then, changes the V_{OS} of the input stage. This problem is more apparent with the larger devices and packages, i.e. when there is more surface to be stressed. Thus, the most sensitive would be a large quad in a 14-pin DIP; the least, a small single op amp in a metal can (TO-5) package.

To improve the accuracy of the BI-FET op amps, the offset voltage should be nulled after the devices are in their final circuits. The BI-FET offset voltage has an associated drift of between $2 \mu\text{V}/^\circ\text{C}$ and $10 \mu\text{V}/^\circ\text{C}$ (depending on the device) for every millivolt of offset at room temperature. The V_{OS} null

schemes will affect the offset drift; it is equally likely that the drift will increase rather than decrease, because the sources of BI-FET V_{OS} are complex.

The easiest V_{OS} cancelling technique is the trim scheme provided in the op amp's datasheet. The LF411 and LF441 require a 10k potentiometer between the trim pins (1 and 5), with the wiper to V^- . The LF356 family requires a 25k pot with the wiper to V^+ . A larger pot would extend the trim range, but this is not necessary since the specified resistance is sufficient to correct even the worst case V_{OS} .

Dual and quad op amps have no trim pins, so they are used most often when small offsets can be tolerated. An external bias voltage can be added at the input to cancel the V_{OS} at a given ambient temperature (T_A). Typical trim schemes are given in Applications Note AN-3.

In general, the reasons for the Abs. Max. ratings and recommendations are a combination of convention and necessity. Exceeding the ratings and recommendations does not always mean death of the op amp, but the reliability and performance of the amplifier are kept at their highest when the part is used properly and protected from excesses.

References:

- Brokaw, Paul: "An IC Amplifier Users' Guide to Decoupling & Grounding or Making Things Go Right", Electronic Products, December 1977, pp. 45-53.
- Frederiksen, Thomas M: "Intuitive IC Op Amps", R. R. Donnelley & Sons, 1984, p. 40: explanation of LF356 output stage; pp. 271-272: power supply sequencing.
- Pease, Robert A: "Bounding, Clamping Techniques Improve Circuit Performance", EDN, November 10, 1983, pp. 277-289.

Multivibrator/Timer CAD

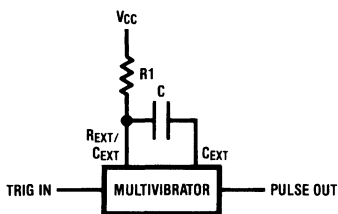
National Semiconductor
Application Brief 7
Bob Nelson



Circuit design making use of monolithic multivibrators and timers can be most easily and quickly done making use of a simple CAD (computer aided design) program. Fortunately, only 2 basic multivibrator types and 1 timer design type exist, reducing the program requirements to 3 sets of algorithms.

Figure 1 provides a view of the basic multivibrator and the t_{ON} (pulse width) determining resistor and capacitor (R1 and C). the Advanced Bipolar Logic Databook by National Semiconductor Corporation should be consulted for the specific device pinout and functions.

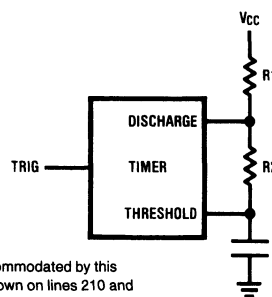
Figure 2 is a block diagram showing the basic timer and the t_{ON} (pulse width) determining resistor and capacitor (R1 and C) along with the t_{OFF} determining resistor R2 (required if astable operation is required). The Linear Databook by National Semiconductor should be consulted for the specific device pinout and additional device functions.



TL/H/5248-1

Multivibrators accommodated by this program are shown in lines 130 through 200 of the listing.

FIGURE 1



The timers accommodated by this program are shown on lines 210 and 220 of the listing.

FIGURE 2

TL/H/5248-2

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100 For I=0 to 10:PRINT:NEXT
110 PRINT"MULTIV by Bob Nelson — 2/1/83":PRINT:PRINT
120 PRINT"The following multivibrators are available for design:":Print
130 PRINT"DM54/74121      One Shots                0"
140 PRINT"DM54/74LS122   Retriggerable One Shots with Clear  1"
150 PRINT"DM54/74123     Dual Retriggerable One Shots with Clear  2"
160 PRINT"DM54/74L123    Dual Retriggerable One Shots with Clear  3"
170 PRINT"DM54/74LS123   Dual Retriggerable One Shots with Clear  4"
180 PRINT"DM54/74LS221   Dual One Shots with Schmitt-Trigger Inputs 5"
190 PRINT"DM86/9601      Retriggerable One Shots                6"
200 PRINT"DM86/9602      Dual Retriggerable, Resettable One Shots 7"
210 PRINT"LM555/555C     Timer                                    8"
220 PRINT"LM556/556C     Dual Timer                                9"
230 PRINT:INPUT"Enter number representing choice . . . . .",N:PRINT
240 IF N>9 THEN 100
250 FOR I=0 TO N:READ K:READ RN:READ RX:NEXT:IF K<>.693 THEN 270
260 PRINT"Astable or Monostable (A/M)":INPUT M$
270 INPUT"Ton in nanoSeconds":T1:IF M$<>"A" THEN 300
280 INPUT"Toff in nanoSeconds":T2:IF 2*T2=<T1 THEN 300
290 PRINT"Toff cannot exceed 50% of Ton":PRINT:GOTO 270
300 INPUT"R1 in Kohms":R1:GOSUB 740:IF M$<>"A" THEN 320
310 INPUT"R2 in Kohms":R2
320 IF T1>0 AND R1>0 THEN 340

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330 INPUT"C in picoFarads";C
340 IF K = .693 THEN 530
350 IF T1 > 0 AND R1 > 0 THEN 490
360 IF T1 > 0 AND C > 0 THEN 450
370 IF R1 > 0 AND C > 0 THEN 410
380 IF R1 > 0 THEN 400
390 R1 = RN:GOSUB 730:GOTO 350
400 GOSUB 710:GOTO 690
410 IF K = 0 THEN 430
420 T1 = K*C*(R1 + .7):GOTO 440
430 T1 = .7*C*R1
440 GOSUB 720:GOTO 690
450 IF K = 0 THEN 470
460 R1 = T1/(K*C - .7):GOTO 480
470 R1 = T1/(.7*C)
480 GOSUB 730:GOTO 690
490 IF K = 0 THEN 510
500 C = T1/(K*(R1 + .7)):GOTO 520
510 O = T1/(.7*R1)
520 GOSUB 790:GOTO 690
530 IF T1 = 0 THEN 570
540 IF T2 > 0 AND R1 > 0 AND R2 > 0 THEN 680
550 IF R1 > 0 AND T2 = 0 AND R2 = 0 THEN 680
560 IF C > 0 THEN 650
570 IF R1 = 0 THEN 600
580 IF C > 0 THEN 620
590 IF R1 > 0 THEN 610
600 R1 = RN:GOSUB 730:GOTO 530
610 GOSUB 710
620 T1 = K*(R1 + 2*R2)*C:T2 = K*R2*C:GOSUB 720:IF M$ <> "A" THEN 640
630 PRINT"Ton = ";T1;"nS"
640 GOTO 690
650 R2 = T2/(K*C):R1 = (T1/(K*C)) - 2*R2:GOSUB 730:IF M$ <> "A" THEN 670
660 PRINT"R2 = ";R2;"Kohms"
670 GOTO 690
680 C = (T1 + T2)/(K*(R1 + 2*R2)):GOSUB 790
690 PRINT:PRINT"Try same part again(Y/N)";:INPUT A$:IF A$ <> "N" THEN 270
700 END
710 PRINT"*****INSUFFICIENT DATA*****": RETURN
720 PRINT"Ton = ";T1;"nS":RETURN
730 PRINT"R1 = ";R1;"Kohms"
740 IF R1 > = RN THEN 760
750 PRINT"***** ??STABILITY - R1 < ";RN;"Kohms *****"
760 IF R1 = < RX THEN 780
770 PRINT"***** ??ACCURACY - R1 > ";RX;"Kohms *****"
780 RETURN
790 PRINT"C = ";C;"pF"
800 IF C > 0 THEN GOTO 820
810 GOSUB 710:GOTO 840
820 IF C > 1000 THEN 840
830 PRINT"***** ??ACCURACY - C < 1000 Pf *****"
840 RETURN
850 DATA 0, 1.4, 40, .45, 5, 260, .32, 5, 50, .33, 5, 400, .45, 5, 260
860 DATA .45, 1.4, 100, .31, 5, 50, .32, 5, 50, .693, .3, 10000, .693, .3, 10000

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Fluid Level Control Systems Utilizing the LM1830

National Semiconductor
Application Brief 10
Bruce J. Rogers
Mitchell Lee



Abstract. The LM1830 fluid level detector is a device intended to signal the presence or absence of aqueous solutions. This application brief shows how to implement HIGH/LOW limit control applications utilizing this device.

Many opportunities exist for a device that can reliably control the operation of pumps or solenoid actuated valves in fluid level control applications. Applications include sump pumps, bilge pumps, washing machines, humidifiers, plating baths, continuous replenishment photographic processors, coffee makers, municipal water and waste treatment plants, cooling towers, refrigeration equipment and others.

Classically, these needs have been met by various mechanical arrangements such as float valves or diaphragm actuated switches. These devices are bulky, inaccurate and, because they contain moving parts, unreliable—often with disastrous results when they fail. They are easily disabled by debris or environmental problems such as ice. They can be expensive when used to control the level of corrosive fluids such as plating baths or detergents, or when used to control large differences in depth such as in municipal water towers. Mechanical control devices are prone to false actuation in vehicular applications (such as bilge pump controls) due to their own inertia. In many applications such as coffee makers, they are too bulky to fit within the confines of the package. By utilizing electronic means based on the LM1830, problems inherent in mechanical solutions are overcome and a reliable, cost effective approach to fluid level control is made possible.

The LM1830 is a monolithic bipolar integrated circuit designed to detect the presence or absence of aqueous fluids. An AC signal generated on-chip is passed through two probes within the fluid. A detector determines the presence of the fluid by using the probes in a voltage divider circuit and measuring the signal level across the probes. An AC signal is used to prevent plating or dissolving of the probes as occurs when a DC signal is used. A pin is available for connecting an external resistance in cases where the fluid impedance is not compatible with the internal 13 k Ω divider resistance.

The addition of a CD4016 quad CMOS analog switch (Figure 1) allows the LM1830 to be used for HIGH/LOW limit control applications. The switch sections are opened and closed by a control signal, where a HIGH level turns the switch ON and a LOW level turns the switch OFF. Grounding the input of one switch section and pulling its output up with a resistor creates an inverter. Probes are connected to the inputs of two of the remaining analog switches. Their outputs are connected to pin 10 of the LM1830

which is the detector input. The remaining section of the CD4016 is used to buffer the open collector output of the LM1830. All of the control inputs of the quad analog switch are tied to this output. The last switch section controls the base of a transistor which in turn drives a relay or solenoid actuated valve.

The start and stop probes are set at their appropriate levels in the fluid container, and the ground return is connected to a third probe located at a depth greater than the start and stop probes. If the container is conductive, it may be used as the ground return. Let's assume we have a situation where we wish to empty the container when fluid reaches a predetermined level [sump or bilge pump, Figure 1(a)]. With no fluid covering either of the probes, pin 12 of the LM1830 switches LOW. This disables the relay and enables the analog switch connected to the start probe. Fluid eventually fills the container, covering the start probe. When this occurs, the output of the LM1830 switches HIGH and the pump relay is enabled, thereby draining the container. At the same time, the analog switch used as an inverter enables the analog switch connected to the stop probe and disables the start probe. Draining continues until the stop probe is above the level of fluid in the container. Then the output of the LM1830 switches LOW, disabling the relay (halting the drain operation) and switching the start probe back to its active state.

By reversing the labeling on the probes, as well as reversing the polarity of the relay drive, a container "fill" control is implemented such as would be used in a water tower. Necessary circuit changes are shown in Figure 1(b).

A pump control for a waste water holding tank in a photographic darkroom has been implemented with this circuitry. This replaced a float actuated system which failed consistently due to the corrosive nature of the chemicals used in photographic processing. With one year of continuous service, no failures have occurred in this system. Furthermore, there is no evidence of plating on the sense electrodes, in spite of the fact that the waste water is loaded with silver ions. A plastic holding tank is used, with stainless steel bolts inserted through holes drilled in the tank as sense probes (Figure 2). A solid-state relay controls a 1/4 HP pump motor to empty the tank.

Obviously, careful selection of probe materials must be made to maximize reliability with this system. Excellent sources of information on materials in corrosive environments are available in publications such as Omega's *Temperature Measurement Handbook*, or Eastman Kodak's *Darkroom Design Manual*.

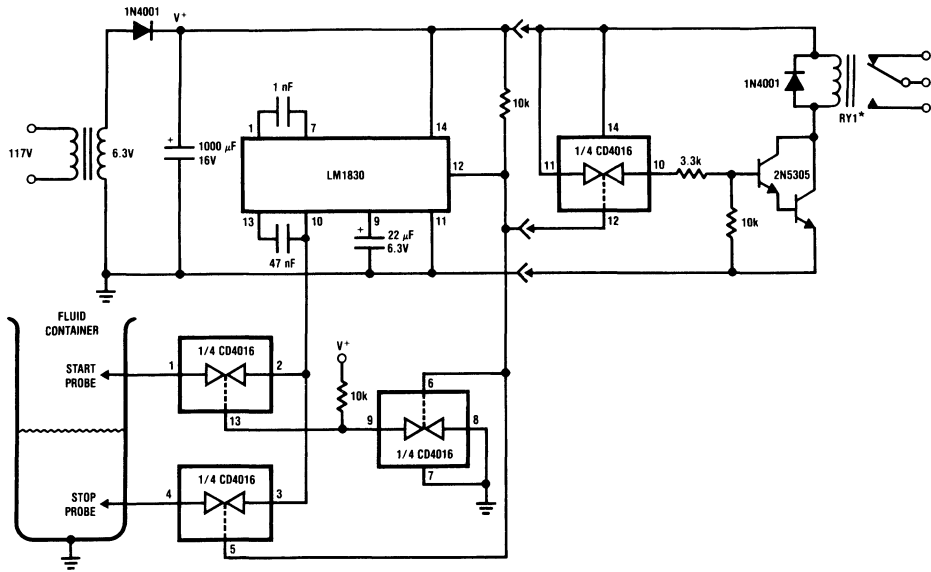
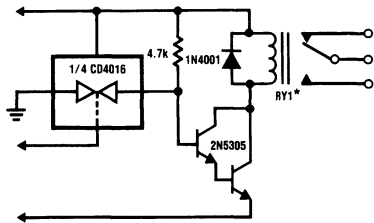


FIGURE 1(a). "Emptying" Processes are Controlled with this Circuit

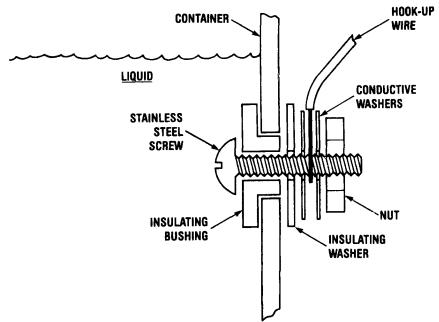
TL/H/5071-1



*RY1 = Magnecraft Part # W388CQX-5

FIGURE 1(b). Filling Processes are Implemented with this Output Circuit and Relabeled Probes

TL/H/5071-2



A sealing compound applied externally protects hook-up wire and prevents leaks.

FIGURE 2. Typical Probe Installation

TL/H/5071-3

High-Efficiency Regulator has Low Drop-Out Voltage

National Semiconductor
Application Brief 11



Conventional regulators have a high drop-out voltage that is a function of the total output current. However, with just a regulator chip, an external transistor and a few passive components, this design forms a high output current regulator with a limited input voltage and high efficiency. The circuit presented has a drop-out of 0.7V at 5A load current and 1.3V at a current level of as high as 10A.

The circuit output voltage equals that of PNP regulator U1 and may be expressed as $V_{OUT} = V_{REF} (R1 + R2)/R1$ where V_{REF} equals U1's reference voltage of 1.2V. To compensate for bias-current errors and to keep the extra quiescent current that is induced by this resistor network to a few μA , resistor R1 is set at 28 k Ω . Thus for a 5V regulated output voltage, R2 is set at 88.7 k Ω . In addition, the output voltage can be adjusted between 3V and 24V by varying R2.

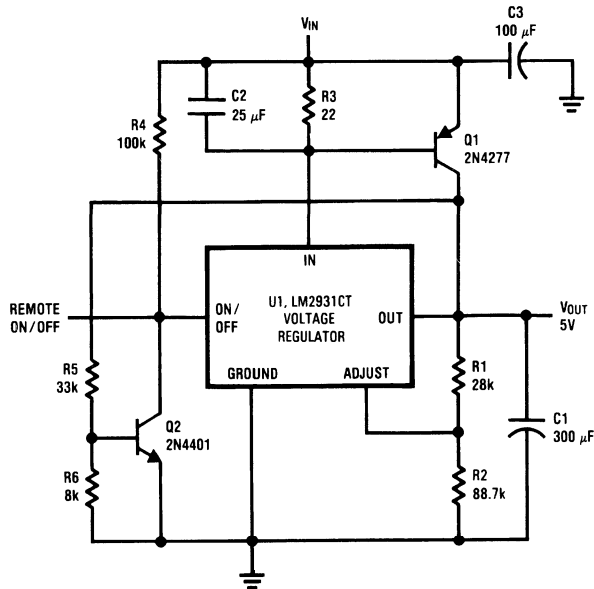
The circuit can handle a great deal of current because of external PNP transistor Q1. At high current levels, the circuit's drop-out voltage is a function of the saturation voltage of the PNP device. As a result, Q1 must have low saturation levels for V_{CE} and V_{BE} along with a high beta. In addition, the maximum output current is equal to the maximum output sink of regulator U1 multiplied by the maximum beta of Q1. A germanium transistor, such as a 2N4277 for the external pass element, satisfies the above requirements. For the

components shown, the circuit gives excellent regulation at $V_{IN} = 5.7V$ up to 5A in load current, giving a drop-out of only 0.7V.

U1 is biased to a minimum of 30 mA by a resistor R3, which also functions as a bleeder resistor for Q1. The on-off pin of U1 permits extra remote on-off control and current-limiting functions for the circuit. Pulling this pin to ground enables the circuit, whereas keeping it open disables the circuit and leaves the regulator in the standby mode. The ratio R5:R6 limits the maximum output current. When the load current exceeds this maximum, the output voltage begins to fall and the voltage across R6 decreases. This low voltage cuts off transistor Q2, thereby disabling the circuit output. As a result, transistor Q1 and the load are protected from overdrive and damage.

EFFICIENCY

Using National Semiconductor's regulator LM2931CT, external transistors Q1 and Q2, and a few passive components, this circuit forms a high-current regulator having a low drop-out. For the components shown in the figure, the regulator has a drop-out of 0.7V at 5A load current and 1.3V at a level as high as 10A. The on-off pin of regulator U1 provides remote control, while transistor Q2 limits the maximum output current.



TL/H/5523-1

Wide Adjustable Range PNP Voltage Regulator

National Semiconductor
Application Brief 12



What happens when the need arises for a regulator voltage that isn't matched by your stock of fixed voltage I/C regulators? For the standard NPN pass transistor regulators (LM340 for example) the answer may be as simple as adding a resistor (R1) in the ground pin (*Figure 1*). The new output voltage (V_O) will then be:

$$V_O = V_{REG} + I_Q \times R1 \quad (1)$$

where: V_{REG} is the original regulator output voltage,
I_Q is the regulator's quiescent current.

But if the need is also for a low drop across the regulator, then a PNP pass regulator is required. Simply adding a resistor in the ground pin doesn't work, since the regulator internal current varies too much because of increased base drive to compensate for lower PNP beta. However, if a zener is used instead of a resistor, the higher voltages can be accommodated (*Figure 2*). The new output voltage (V_O) is:

$$V_O = V_{REG} + V_Z \quad (2)$$

where V_Z is the zener voltage.

As V_{REG} is constant, the output voltage regulation will depend largely on the zener voltage (V_Z) and its dynamic impedance.

The zener voltage will vary slightly with the current flowing through. Let's take the popular LM2931Z PNP regulator from National Semiconductor as an example of variation of the quiescent current. When the regulator load changes from 50 mA to 150 mA, the zener current will increase by

12.5 mA. The zener voltage variation due to this current change will only be a few hundred mV. That is, the output voltage will vary slightly, but not as much (as high as a few volts) as with a resistor to ground. Thus, a much better regulated output voltage is maintained.

One advantage inherent to this circuit is the ability to achieve higher output voltages than the normal regulator rating. The maximum regulator output is limited by the breakdown of its internal circuitry. However, carefully selecting the zener to keep the input and ground pin differential voltage well below the breakdown, the input is allowed to exceed its maximum rating. For example, a 5V 3-terminal LM2931Z PNP regulator (maximum operating input voltage = 26V) can become a 56V regulator with a 51V zener. And the input voltage can be as low as 56.6V with a load current of 150 mA or less. Most of the PNP regulator's features are still maintained. The short circuit protection may or may not be there, depending on the output voltage and the safe operating area of the output pass PNP transistor.

Capacitors C1 and C2 should have the same values as those specified for normal operation. However, their maximum operating voltage ratings should exceed the input voltage. Capacitor C3 should be located as close as possible to the ground pin to get good decoupling and ensure stable operation. The value of C3 will depend on zener impedance and noise characteristics. The capacitor types must also be rated over the desired operating temperature range.

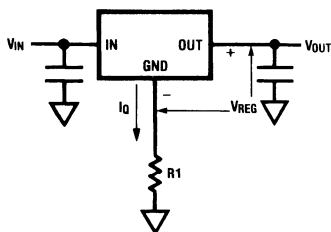


FIGURE 1. NPN Regulator

TL/H/5723-1

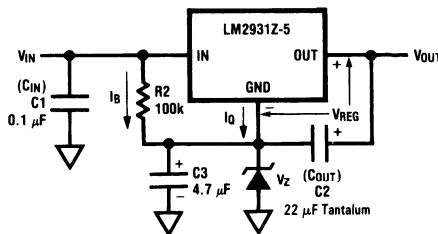


FIGURE 2. PNP Regulator

TL/H/5723-2

Electrostatic Transducers Provide Wide Range Ultrasonic Measurement

National Semiconductor
Application Brief 20
Mitchell Lee



The LM1812 is a complete ultrasonic transceiver on a chip designed for use in a variety of pulse-echo ranging applications. The chip operates by transmitting a burst of oscillations with a transducer and then using the same transducer to listen for a return echo. If an echo of sufficient amplitude is received, the LM1812 detector puts out a pulse of approximately the same width as the original burst. The closer the reflecting object, the earlier the return echo. Echos could be received immediately after the initial burst was transmitted except for the fact that the transducer "rings."

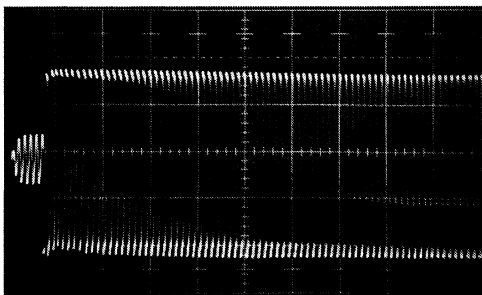
During transmit the transducer is excited with several hundred volts peak to peak, and it operates in a "loudspeaker" mode. Then, when the LM1812 stops transmitting and begins to receive, the transducer continues to vibrate (ring) even though excitation has stopped. The transducer acts as a microphone and produces an AC signal initially the same amplitude as the transmit pulse. This signal dies away as governed by the transducer's damping factor, but as long as detectable ringing remains, the LM1812's detector will be held ON masking any return echos.

This problem is especially troublesome when using piezoelectric transducers owing to their high Q. Ringing in a typical 40 kHz piezoelectric transducer may last as long as 20 ms—masking more than 10 feet of range. Electrostatic transducers, being quite broadband, are practically free of

ring and operate over a wide range. Any ringing is in fact due to the resonant output tank, and not the electrostatic transducer.

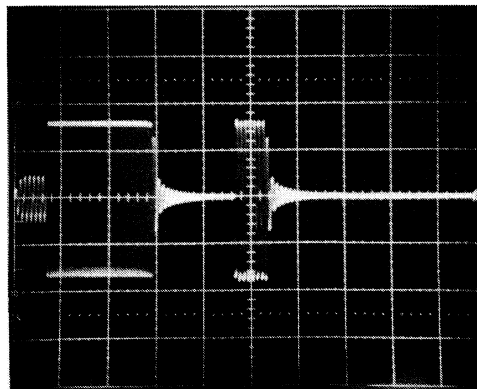
Figures 1 and 2 exemplify the problem. These oscilloscope photos show a 150 μ s transmit pulse (5Vp-p), a high-amplitude (15 to 20 Vp-p) ring signal, and in Figure 2, a return echo. Both are on 5V/div \times 200 μ s/div. Figure 1 shows a typical 40 kHz piezoelectric transducer in operation. The entire 2 ms screen width is completely filled by ring, and echos cannot be seen. The electrostatic circuit is heavily damped, and as shown in Figure 2, echoes can be received after just 600 μ s. In this example, the piezoelectric transducer rings approximately 20 times as long as the electrostatic transducer.

The circuit shown in Figure 3 utilizes an electrostatic transducer to achieve a range of 4" to over 30'. The broadband transducer characteristic simplifies tuning. L6 is designed to resonate at 50 to 60 kHz with the 500 pF transducer capacitance. L1 is tuned to this frequency by watching for maximum echo sensitivity with an oscilloscope at pin 1. A unique output circuit (L6, C, D1, 2, and 3) provides a resonant transmitting stage ($Q = 5$), series resonant receiving network, input protection (D1, D2), and the required 150 V_{DC} bias (C, D3) for the transducer.



TL/H/8632-1

FIGURE 1. Ringing is a Problem for Piezoelectric Transducers (5V/div \times 200 μ s/div)



TL/H/8632-2

FIGURE 2. Wide Band Electrostatic Transducers Offer High Sensitivity and Little Ringing (5V/div \times 200 μ s/div)

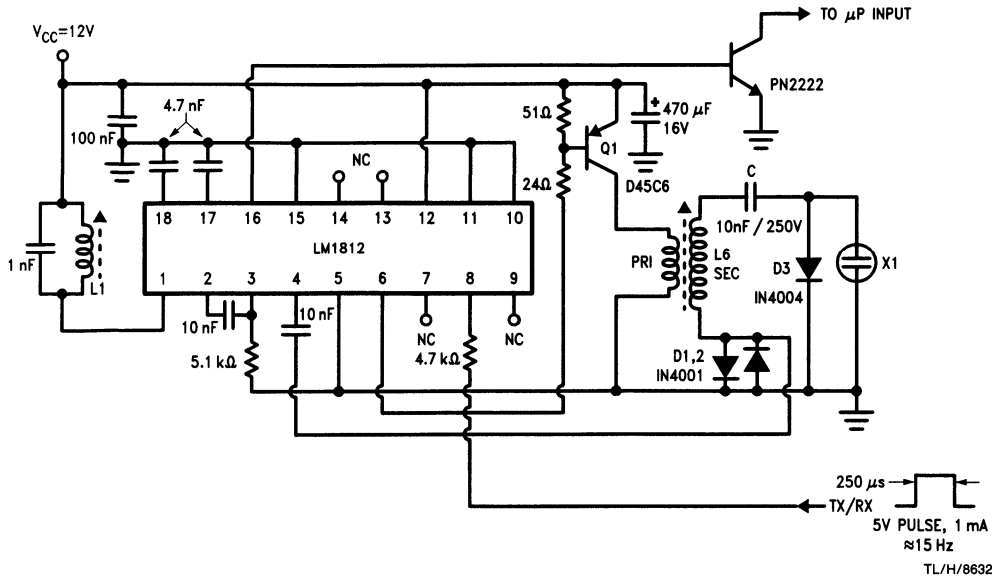


FIGURE 3. Complete Transceiver Circuit Using an Electrostatic Transducer

TL/H/8632-3

PART LIST:

L1	15.8 mH adjustable. #CLN-2A900HM	TOKO
L6	PRIMARY 8 TURNS #24* SECONDARY 110 TURNS #30* POTCORE RM8P-A630-3B7 BOBBIN RM8 PCB1-4 CLIPS 991-393-00	FERROXCUBE
X1	POLAROID TRANSDUCER	POLAROID
Q1	D45C6 $I_C = 5A_{min}$ $V_{CBO} = 40V_{min}$	NSC
C	250V, 10 nF MYLAR	—

*If machine wound, slightly larger wire sizes may be used.

Toko America, Inc. 1250 Feehanville Drive
Mount Prospect, IL 60056
Tel. (312) 297-0070

Ferroxcube 5083 Kings Highway,
Saugerties, NY 12477
Tel. (914) 246-2811

Polaroid Corp.

Commercial Battery Division
784 Memorial Drive,
Cambridge, MA 02139
Tel. (617) 577-2024

National Semiconductor Corp.

2900 Semiconductor Drive
Santa Clara, CA 95051
Tel. (408) 721-5000

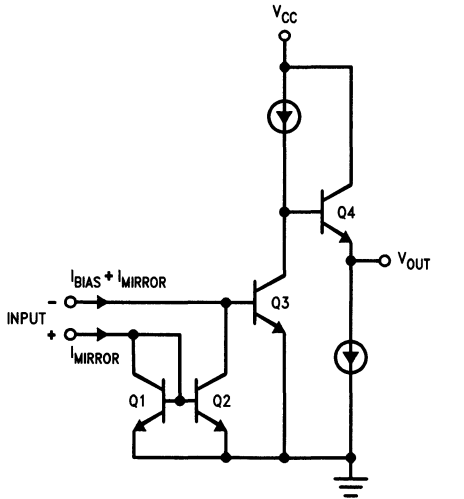
Bench Testing LM3900 and LM359 Input Parameters

National Semiconductor
Application Brief 24
Mitchell Lee



Two input parameters are extremely important in designing circuits with Norton op amps. These are the input bias current, I_{BIAS} , and the mirror gain constant, A_I . The mirror gain is especially important when a Norton amplifier is used as a voltage follower.

A simplified schematic of the LM3900 is shown in Figure 1. The op amp is basically a common emitter amplifier (Q3), with an emitter follower output stage. Added to the base of Q3 is a current mirror (Q1 and Q2). If a fixed current is injected into the non-inverting input and the output is fed back to the inverting input, the output will rise until the current in Q2 matches that flowing in Q1. The currents in the input terminals will not be equal since some current (I_{BIAS}) flows into the base of Q3. This is especially noticeable when the mirror current is very small—for instance in the 1 to 10 μA range. Input currents may also be unequal due to mismatch in the mirror transistors, Q1 and Q2. The degree of matching is called mirror gain, A_I , and is ideally equal to "1".

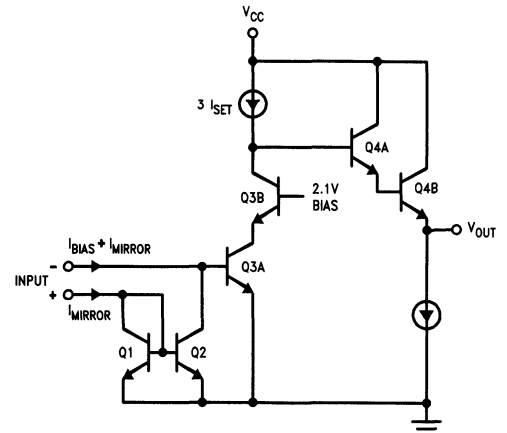


TL/H/5528-1

FIGURE 1. A simplified schematic of the LM3900

The LM359 (Figure 2) differs from the LM3900 in that "Q3" is a cascode stage, and "Q4" is a darlington follower. Also, the internal biasing is variable; set current (I_{SET}) is determined by an external resistor. Gain-bandwidth product, slew rate, input noise, output drive current, input bias current and, of course, supply current all vary with set current.

Any modern text detailing the operation of an op amp will tell you how to bench test its parameters. Norton amplifiers are, however, frequently overlooked and their important input parameters are difficult to test in the usual manner. Two measurements and a simple calculation can provide accurate characterization of I_{BIAS} and A_I .

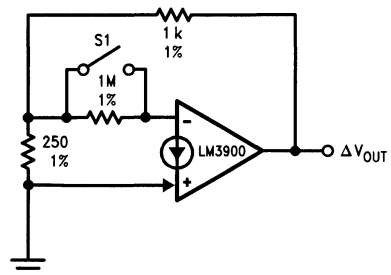


TL/H/5529-2

FIGURE 2. A simplified schematic of the LM359

The test circuit for measurement of I_{BIAS} in the LM3900 is shown in Figure 3. Two voltage measurements are made at the output of the LM3900, one with S1 closed and one with S1 opened. The output voltage increase is equal to the voltage appearing across the 1 M Ω resistor, multiplied by the closed loop gain (A_V) of 5. It is the result of Q3 bias current flowing in the 1 M Ω resistor. For the circuit shown the output voltage increase multiplied by 200 gives the bias current in nanoamperes.

$$I_{BIAS} \text{ (nA)} = 200 \Delta V_{OUT} = \left(\frac{10^9}{A_V \times 1 \text{ M}\Omega} \right) \Delta V_{OUT}$$



TL/H/5529-3

FIGURE 3. I_{BIAS} can be evaluated by measuring the change in output voltage when S1 is opened and closed.

LM3900 mirror gain is measured using the circuit of Figure 4. "R" is selected to provide the desired mirror current. The voltage across each "R" is measured, and their ratio is equal to the mirror gain, A_I . As previously mentioned, the

mirror gain is affected by the presence of I_{BIAS} . Where I_{BIAS} is a significant part of the mirror current, the formula (true for the LM3900 and the LM359) for A_I becomes

$$A_I = \frac{(V_2) - R I_{BIAS}}{V_1}$$

Many of the LM359's data sheet parameters, including I_{BIAS} , are measured with $I_{SET} = 0.5 \text{ mA}$. Three times this current flows in the collector of Q3A, making its bias current about $15 \text{ }\mu\text{A}$. The LM3900 has a corresponding Q3 collector current of only $3 \text{ }\mu\text{A}$, and its $I_{BIAS} = 30 \text{ nA}$. However, the

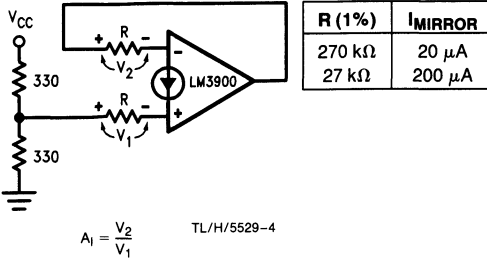


FIGURE 4. This circuit allows the measurement of the mirror gain, "A_I"

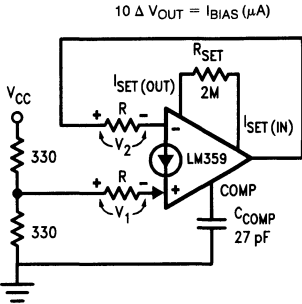


FIGURE 5. I_{BIAS} is measured with a set current of $500 \text{ }\mu\text{A}$

LM3900 doesn't have a 400 MHz gain-bandwidth product. The mirror gain is measured with $I_{SET} = 5 \text{ }\mu\text{A}$, making I_{BIAS} so small it has little affect on the measurement. In a practical application I_{BIAS} may be a significant part of the mirror

current, adding an unpredictable error term to the DC biasing equations. This circumstance can be avoided by sizing the mirror current at least $\frac{1}{3} I_{SET}$.

Figures 5 and 6 show how to measure and calculate I_{BIAS} and A_I for the LM359. R_{SET} is selected to provide the appropriate set current and C_{COMP} is added for stability. I_{BIAS} and A_I are measured with the same set currents used in the data sheet.

All of the test circuits assume $V_{CC} = 12\text{V}$. Accuracy is as good as the resistors and meter used. Matching is important for the two "R's" used in Figures 4 and 6. 1% tolerance is recommended for each resistor (5% resistors can be sorted for accuracy) in Figure 3, and the 100 k Ω resistor in Figure 5. Most $3\frac{1}{2}$ digit DVM's have sufficient accuracy for the voltage measurements; input impedance must be at least 10 M Ω to prevent circuit loading in the mirror gain tests. Detailed information concerning the use of the LM3900 and LM359 can be found in their data sheets and in AN-72.

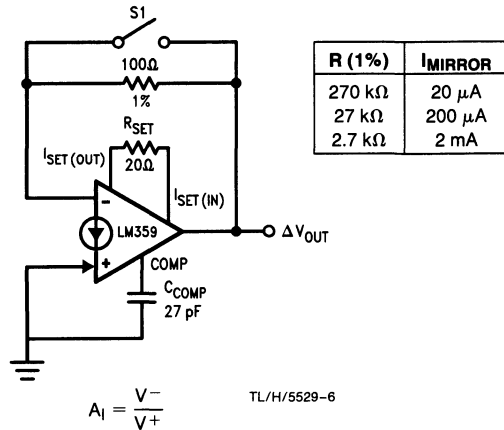


FIGURE 6. Mirror gain, A_I , is measured with $I_{SET} = 5 \text{ }\mu\text{A}$

'Dithering' Display Expands Bar Graph's Resolution

National Semiconductor
Application Brief 25
Robert A. Pease



Commercially available bar-graph chips such as National's LM3914 offer an inexpensive and generally attractive way of discerning 10 levels of signal. If 20, 30, or more steps of resolution are required, however, bar-graph displays must be stacked, and with that, the circuit's power drain, cost and complexity all rise. But the techniques used here for creating a scanning-type "dithering" or modulated display will expand the resolution to 20 levels with only one 3914 or, alternately, make it possible to implement fine-tuning control so that performance approaching infinite resolution can be achieved.

The light-emitting-diode display arrangement for simply distinguishing 20 levels is achieved with a rudimentary square-wave oscillator, as shown in Figure 1. Here, the LM324 oscillator, running at 1 kHz, drives a 60 mV peak-to-peak signal into pin 8 of the 3914.

Now, the internal reference circuitry of the 3914 acts to force pin 7 to be 1.26V above pin 8, so that pins 4 and 8 are at an instantaneous potential of 4.0 mV plus a 60 mV p-p square wave, while pins 6 and 7 will be at 1.264V plus a 60 mV p-p square wave. Normally, the first LED at pin 1 would turn on when V_{IN} exceeded 130 mV, but because of the dither caused by the AC component of the oscillator's output, the first LED now turns on at half intensity when V_{IN} rises above the aforementioned value. Full intensity is achieved when V_{IN} = 190 mV.

When V_{IN} rises another 70 mV or so, the first LED will fall off to half brightness and the second one will begin to glow. When V_{IN} reaches 320 mV, the first LED will go off and the second will turn on fully, and so on. Thus 20 levels of brightness are easily obtained.

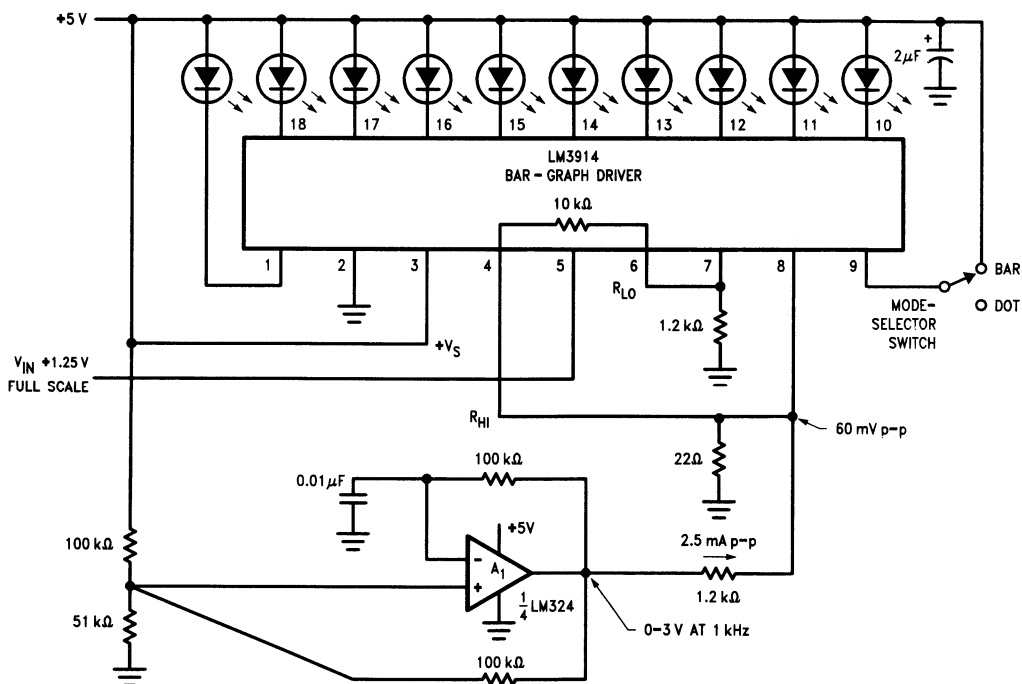
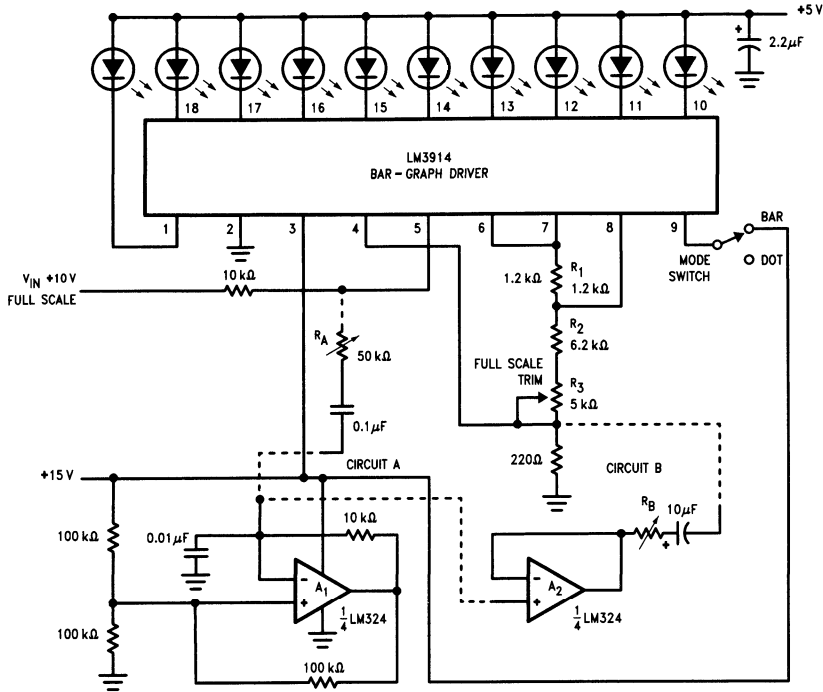


FIGURE 1. Half tones. Input-signal biasing on LM3914 bar-graph chip is set by the instantaneous output of a low-amplitude square-wave oscillator so that bar-graph resolution can be doubled. Each of 10 LEDs now has a fully-on and a partially-on mode, making 20 states discernible.

TL/H/8739-1



TL/H/8739-2

FIGURE 2. Spectrum. Greater resolution, limited only by the ability of the user to discern relative brightness, is achieved by employing a triangular-wave oscillator and more sensitive control circuitry to set the voltage levels and thus light levels of corresponding LEDs. Two RC networks, circuits A and B, provide required oscillator coupling and attenuation. B replaces A if oscillator cannot suffer heavy loading.

Similarly, greater resolution can be achieved by employing a triangular-wave oscillator and two simple RC networks as seen in *Figure 2*. Here, by means of circuit A, this voltage is capacitively coupled, attenuated, and superimposed on the input voltage at pin 5 of the LM3914. With appropriate setting of the 50 kΩ potentiometer, each incremental change in V_{IN} can be detected because the glow from each LED can be made to spread gradually from one device to the next. Of course, if the signal-source impedance is not low or linear, the AC signals coupled into the input circuit can cause false readings at the output. In this case, the circuit in block

B should be used to buffer the output of the triangular-wave oscillator.

The display is most effective in the dot mode, where supply voltages can be brought up to 15V. If the circuit's bar mode is used, the potentials applied to the LEDs should be made no greater than 5V to avoid overheating.

To trim the circuit, set the LM3914's output to full scale with R_3 . R_A or R_B should then be trimmed so that when one LED is lit, any small measured change of V_{IN} will cause one of the adjacent LEDs in the chain to turn on.

Instrumentation Amplifier

National Semiconductor
Linear Brief 1



LB-1

The differential input single-ended output instrumentation amplifier is one of the most versatile signal processing amplifiers available. It is used for precision amplification of differential dc or ac signals while rejecting large values of common mode noise. By using integrated circuits, a high level of performance is obtained at minimum cost.

Figure 1 shows a basic instrumentation amplifier which provides a 10 volt output for 100 mV input, while rejecting greater than $\pm 11V$ of common mode noise. To obtain good input characteristics, two voltage followers buffer the input signal. The LM102 is specifically designed for voltage follower usage and has 10,000 M Ω input impedance with 3 nA input currents. This high of an input impedance provides two benefits: it allows the instrumentation amplifier to be used with high source resistances and still have low error; and it allows the source resistances to be unbalanced by over 10,000 Ω with no degradation in common mode rejection. The followers drive a balanced differential amplifier, as shown in Figure 1, which provides gain and rejects the common mode voltage. The gain is set by the ratio of R_4 to R_2 and R_5 to R_3 . With the values shown, the gain for differential signals is 100.

Figure 2 shows an instrumentation amplifier where the gain is linearly adjustable from 1 to 300 with a single resistor. An LM101A, connected as a fast inverter, is used as an attenuator in the feedback loop. By using an active attenuator, a

very low impedance is always presented to the feedback resistors, and common mode rejection is unaffected by gain changes. The LM101A, used as shown, has a greater bandwidth than the LM107, and may be used in a feedback network without instability. The gain is linearly dependent on R_6 and is equal to $10^{-4} R_6$.

To obtain good common mode rejection ratios, it is necessary that the ratio of R_4 to R_2 match the ratio of R_5 to R_3 . For example, if the resistors in circuit shown in Figure 1 had a total mismatch of 0.1%, the common mode rejection would be 60 dB times the closed loop gain, or 100 dB. The circuit shown in Figure 2 would have constant common mode rejection of 60 dB, independent of gain. In either circuit, it is possible to trim any one of the resistors to obtain common mode rejection ratios in excess of 100 dB.

For optimum performance, several items should be considered during construction. R_1 is used for zeroing the output. It should be a high resolution, mechanically stable potentiometer to avoid a zero shift from occurring with mechanical disturbances. Since there are several ICs operating in close proximity, the power supplies should be bypassed with 0.01 μF disc capacitors to insure stability. The resistors should be of the same type to have the same temperature coefficient.

A few applications for a differential instrumentation amplifier are: differential voltage measurements, bridge outputs, strain gauge outputs, or low level voltage measurement.

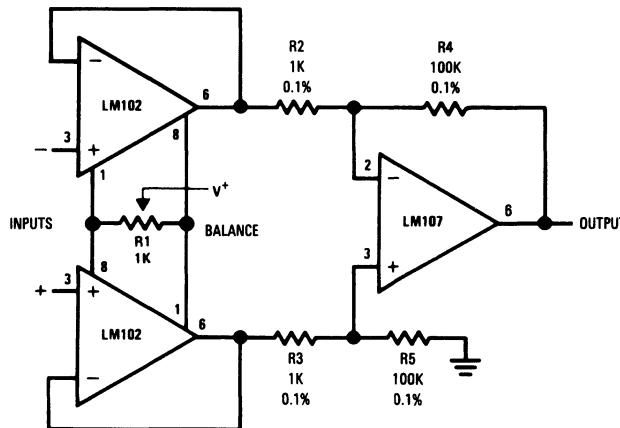
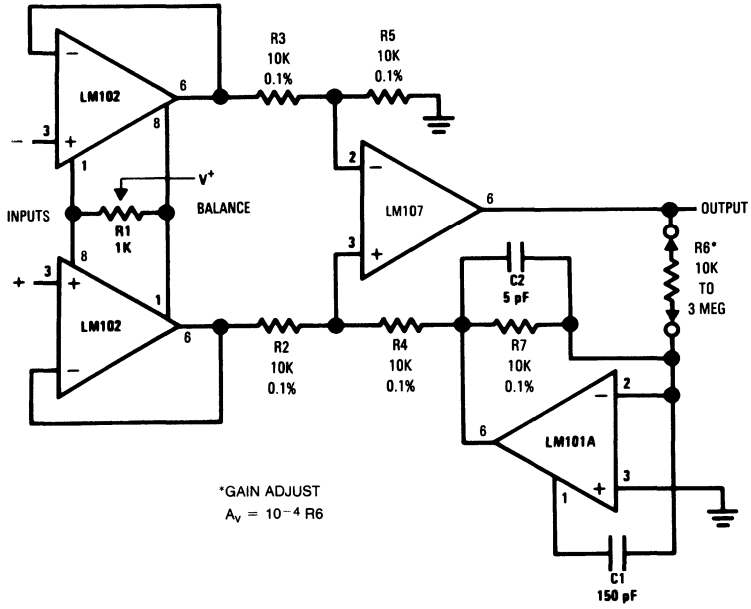


FIGURE 1. Differential-Input Instrumentation Amplifier

TL/H/8501-1



TL/H/8501-2

FIGURE 2. Variable Gain, Differential-Input Instrumentation Amplifier

Feedforward Compensation Speeds Op Amp



Robert J. Widlar
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Mexico

A feedforward compensation method increases the slew rate of the LM101A from $0.5/\mu\text{s}$ to $10\text{V}/\mu\text{s}$ as an inverting amplifier. This extends the usefulness of the device to frequencies an order of magnitude higher than the standard compensation network. With this speed improvement, IC op amps may be used in applications that previously required discrete components. The compensation is relatively simple and does not change the offset voltage or current of the amplifier.

In order to achieve unconditional closed loop stability for all feedback connections, the gain of an operational amplifier is rolled off at 6 dB per octave, with the accompanying 90 degrees of phase shift, until a gain of unity is reached. The frequency compensation networks shape the open loop response to cross unity gain before the amplifier phase shift exceeds 180 degrees. Unity gain for the LM101A is designed to occur at 1 MHz. The reason for this is the lateral PNP transistors used for level shifting have poor high frequency response and exhibit excess phase shift about 1 MHz. Therefore, the stable closed loop bandwidth is limited to approximately 1 MHz.

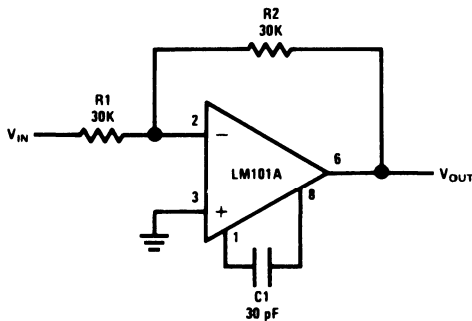
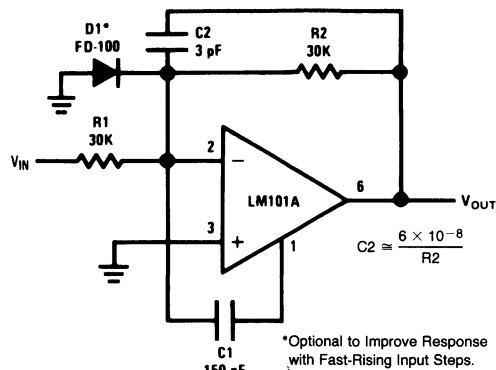


Figure 1. Standard frequency compensation

Usually, the LM101A is frequency compensated by a single 30 pF capacitor between Pins 1 and 8, as shown in Figure 1. This gives a slew rate of $0.5\text{V}/\mu\text{s}$. The feedforward is achieved by connecting a 150 pF capacitor between the inverting input, Pin 2, and one of the compensation terminals, Pin 1, as shown in Figure 2. This eliminates the lateral PNP's from the signal path at high frequencies. Unity gain bandwidth is 10 MHz and the slew rate is $10\text{V}/\mu\text{s}$. The diode can be added to improve slew with high speed input pulses.

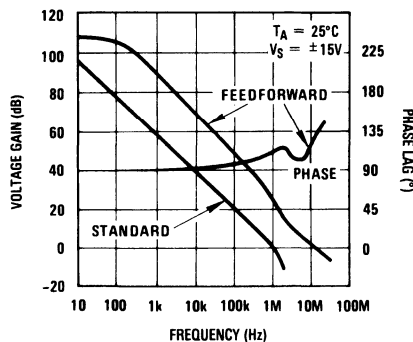


*Optional to Improve Response with Fast-Rising Input Steps.

TL/H/7327-2

Figure 2. Feedforward frequency compensation

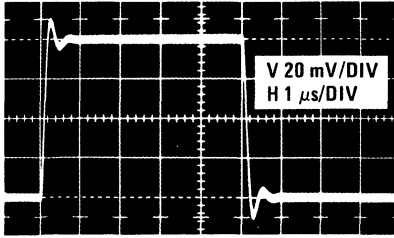
Figure 3 shows the open loop response in the high and low speed configuration. Higher open loop gain is realized with the fast compensation, as the gain rolls off at about 6 dB per octave until a gain of unity is reached at about 10 MHz.



TL/H/7327-3

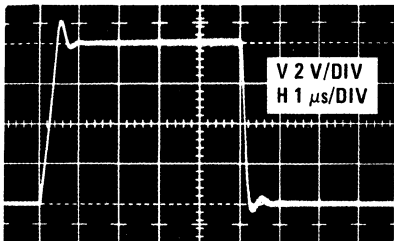
Figure 3. Open loop response for both frequency compensation networks

Figures 4 and 5 show the small signal and large signal transient response. There is a small amount of ringing; however, the amplifier is stable over a -55°C to $+125^{\circ}\text{C}$ temperature range. For comparison, large signal transient response with 30 pF frequency compensation is shown in Figure 6.



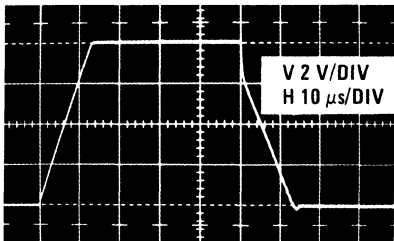
TL/H/7327-4

Figure 4. Small signal transient response with feedforward compensation



TL/H/7327-5

Figure 5. Large signal transient response with feedforward compensation

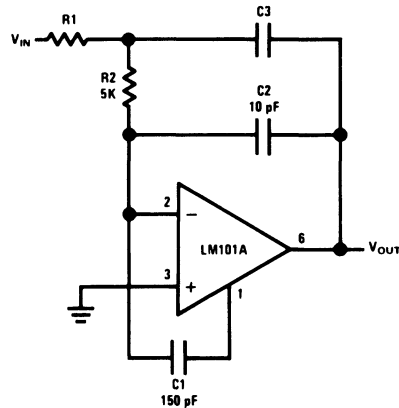


TL/H/7327-6

Figure 6. Large signal transient response with standard compensation

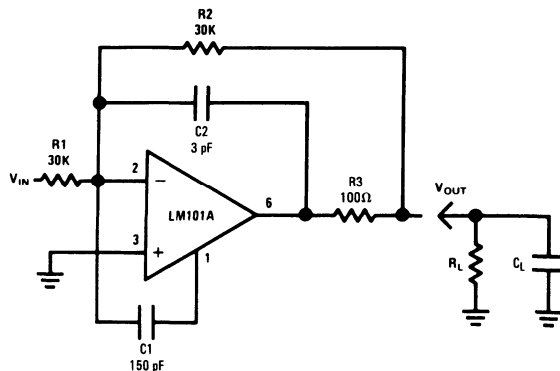
As with all high frequency, high-gain amplifiers, certain precautions should be taken to insure stable operation. The power supplies should be bypassed near the amplifier with .01 μF disc capacitors. Stray capacitance, such as large lands on printed circuit boards, should be avoided at Pins 1, 2, 5, and 8. Load capacitance in excess of 75 pF should be decoupled, as shown in Figure 7; however, 500 pF of load capacitance can be tolerated without decoupling at the expense of bandwidth by the addition of 3 pF between Pins 1 and 8. A small capacitor C_2 is needed as a lead across the feedback resistor to insure that the rolloff is less than 12 dB per octave at unity gain. The capacitive reactance of C_2 should equal the feedback resistance between 2 and 3 MHz. For integrator applications, the lead capacitor is isolated from the feedback capacitor by a resistor, as shown in Figure 8.

Feedforward compensation offers a marked improvement over standard compensation. In addition to having higher bandwidth and slew, there is vanishingly small gain error from DC to 3 kHz, and less than 1% gain error up to 100 kHz as a unity gain inverter. The power bandwidth is also extended from 6 kHz to 250 kHz. Some applications for this type of amplifier are: fast summing amplifier, pulse amplifier, D/A and A/D systems, and fast integrator.



TL/H/7327-8

Figure 8. Fast integrator



TL/H/7327-7

Figure 7. Capacitive load isolation

Worst Case Power Dissipation in Linear Regulators

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 Mexico

The most frequent cause of failures of voltage regulators is excessive dissipation in the semiconductor components. Regulators using integrated circuits are no exception to this. In fact, IC regulators are more prone to over-dissipation because they are not generally available in power packages, because complete integrated circuits must be operated at a lower, maximum junction temperature than silicon power transistors, and because the package must be able to dissipate the quiescent operating power of the control circuitry in addition to the power in the pass transistor.

The problems and solutions presented here give examples of the worst case calculations that should be used in designing voltage regulators with ICs. These questions were used in a contest sponsored by National Semiconductor. The entries received clearly showed that engineers have a marked tendency to be overly optimistic about the dissipation capability of the IC regulators as well as the power ratings of the external power transistors used with them. In a surprising number of cases the errors were of such a magnitude to cause almost certain, premature failure of the regulator under the conditions specified. The questions and answers follow:

1. What is the power limited full-load current for a 24V regulator using the LM100 (without a heat sink) when the worst case operating conditions are 125°C ambient and 40V input voltage?

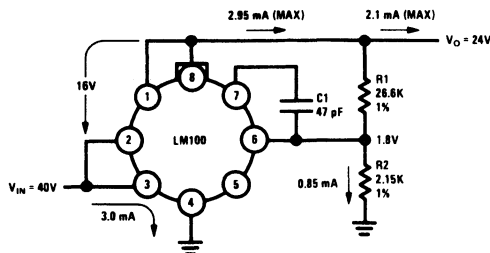
The maximum chip temperature of the LM100 is 150°C, and the thermal resistance of the TO-5 package is 150°C/W when no heat sink is used. The permissible, junction-to-ambient temperature rise is 25°C with a 125°C ambient, so the maximum allowable package dissipation is 167 mW.

The worst case quiescent current of the LM100 is 3.0 mA. With a 40V input voltage, this produces an internal dissipation of 120 mW, even with no load. Therefore, the device can only dissipate another 47 mW in supplying the load current. With 40V in and 24V out, the input-output voltage differential is 16V. This means that 2.95 mA can be supplied through the internal pass transistor without exceeding the ratings.

The divider resistors required on the LM100 feedback to give a 24V output are 26.6k and 2.1k. For a 1.8V sense voltage on the feedback terminal, the divider current will be 0.85 mA. Since this current must be supplied by the integrated circuit, it must be subtracted from the available load current. Hence the maximum output current, taking into account worse case conditions, is 2.1 mA.

2. What is the maximum allowable short-circuit current for an LM104 regulator circuit, with a 2N2095A series pass transistor (without a heat sink) when the worst case input is 20V at an ambient of 85°C?

The 2N2905A, without a heat sink, can dissipate a maximum of 0.6W at 25°C. However, this must be derated by



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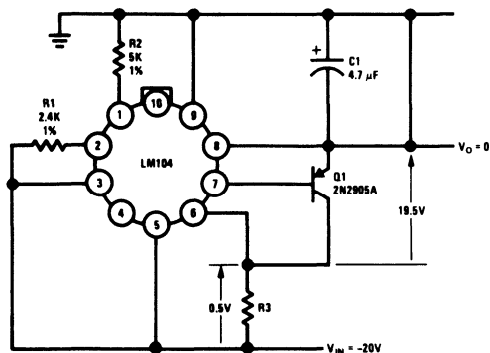
Figure 1. Circuit used in the solution of question 1

3.42 mW/°C for operation at higher temperatures. Since an 85°C ambient is 60°C higher than the temperature at which the transistors are specified, the maximum power rating must be reduced by 205 mW, to 395 mW. With a shorted output, the voltage dropped across the current limit sense resistor is 0.5V, so the voltage across the external pass transistor will be 19.5V for 20V input. This means that the 395 mW maximum dissipation rating will be exceeded for short-circuit currents greater than 20.2 mA.

3. In the previous example, what is the maximum current when the case temperature of the 2N2905A is held to 100°C?

The maximum dissipation of the 2N2905A is 3W at 25°C case temperature, but this must be derated by 17.2 mW/°C for higher case temperatures. With a 100°C case temperature, the allowable dissipation is reduced by 1.29W to 1.71W.

As in the previous example, the voltage across the pass transistor will be 19.5V. This gives a dissipation-limited short-circuit current of 88 mA.



TL/H/8503-2

Figure 2. Circuit used in the solution of questions 2 and 3

4. In the negative regulator with foldback current limiting, what will be the worst case dissipation in the PNP driver, Q_1 , with full load and a 24V input voltage?

The 2N3772 is specified to have a minimum current gain of 15 at 10A and 25°C. It would be reasonable to assume a minimum current gain of 15 at 5A for elevated temperatures where dissipation is most significant. This means that the base current for a 5A load current will be 0.33A. The worst case emitter-base voltage of the 2N3772 at 5A will be about 1V, so the current through the 68Ω emitter-base resistor will be 15 mA. Hence, the PNP driver must supply a total current of 345 mA.

The voltage dropped across the PNP driver will be the 12V input output voltage differential, less the 1V dropped across the current sense resistor and the 1V dropped across the emitter-base junction of the 2N3772. Therefore, the PNP driver operates with 10V across it and dissipates about 3.5W.

5. Could a 2N2905A be used in the example above if the maximum ambient were 85°C?

Even with an infinite heat sink, the 2N2905A can dissipate only 2W at 85°C. *Therefore, it cannot be used.*

The answers to these questions show that the maximum output current of a regulator can be substantially less than might be expected from a cursory analysis of the circuit. Detailed analysis under worst case conditions is necessary to insure a reliable design. These calculations are more important than most other design calculations because errors do not result in somewhat degraded performance that usually shows up in checking out the equipment. Instead, these errors cause failures that do not always show up during checkout, but can occur in field operation.

Additional information on the design of reliable voltage regulators is given in application notes AN-21 and AN-23, available from National Semiconductor.

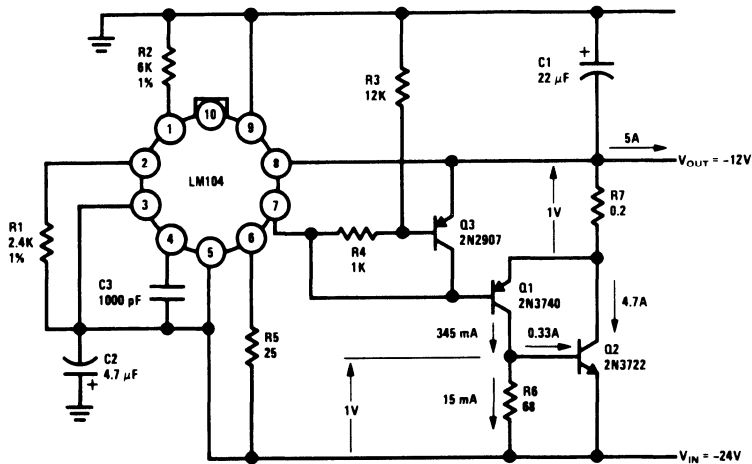


Figure 3. Circuit used in the solution of questions 4 and 5

TL/H/8503-3

Fast Compensation Extends Power Bandwidth

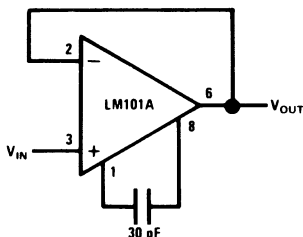


In all IC operational amplifiers the power bandwidth depends on the frequency compensation. Normally, compensation for unity gain operation is accompanied by the lowest power bandwidth. A technique is presented which extends the power bandwidth of the LM101A for non-inverting gains of unity to ten, and also reduces the gain error at moderate frequencies.

In order to achieve unconditional stability, an operational amplifier is rolled off at 6 dB per octave, with an accompanying 90 degrees of phase shift, until a gain of unity is reached. Unity gain in most monolithic operational amplifiers is limited to 1 MHz, because the lateral PNP's used for level shifting have poor frequency response and exhibit excess phase shift at frequencies above 1 MHz. Hence, for stable operation, the closed loop bandwidth must be less than 1 MHz where the phase shift remains below 180 degrees.

For high closed loop gains, less severe frequency compensation is necessary to roll the open loop gain off at 6 dB per octave until it crosses the closed loop gain. The frequency where it crosses must, as previously mentioned, be less than 1 MHz. For closed loop gains between 1 and 10, more frequency compensation must be used to insure that the open loop gain has been rolled off soon enough to cross the closed loop gain before 1 MHz is reached.

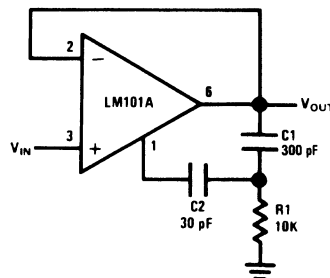
The power bandwidth of an operational amplifier depends on the current available to charge the frequency compensation capacitors. For unity gain operation, where the compensation capacitor is largest, the power bandwidth of the LM101A is 6 kHz. *Figure 1* shows an LM101A with unity gain compensation and *Figure 3* shows the open loop gain as a function of frequency.



TL/H/8455-1

FIGURE 1. LM101A with Standard Frequency Compensation

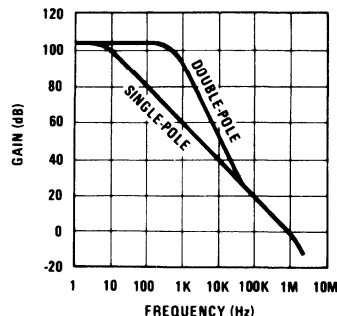
A two-pole frequency compensation network, as shown in *Figure 2*, provides more than a factor of two improvement in power bandwidth and reduced gain error at moderate frequencies. The network consists of a 30 pF capacitor, which sets the unity gain frequency at 1 MHz, along with a 300 pF capacitor and a 10k resistor. By dividing the AC output volt-



TL/H/8455-2

FIGURE 2. LM101A with Frequency Compensation to Extend Power Bandwidth

age with the 10k resistor and 300 pF capacitor, there is less AC voltage across the 30 pF capacitor and less current is needed for charging. Since the voltage division is frequency sensitive, the open loop gain rolls off at 12 dB per octave until a gain of 20 is reached at 50 kHz. From 50 kHz to 1 MHz the 10k resistor is larger than the impedance of the 300 pF capacitor and the gain rolls off at 6 dB per octave. The open loop gain plot is shown in *Figure 3*. To insure sufficient drive to the 300 pF capacitor, it is connected to the output, Pin 6, rather than Pin 8. With this frequency compensation method, the power bandwidth is typically 15-20 kHz as a follower, or unity gain inverter.



TL/H/8455-3

FIGURE 3. Open Loop Response for Both Frequency Compensation Networks

This frequency compensation, in addition to extending the power bandwidth, provides an order of magnitude lower gain error at frequencies from DC to 5 kHz. Some applications where it would be helpful to use the compensation are: differential amplifiers, audio amplifiers, oscillators, and active filters.

High Q Notch Filter

National Semiconductor
Linear Brief 5



The twin "T" network is one of the few RC filter networks capable of providing an infinitely deep notch. By combining the twin "T" with an LM102 voltage follower, the usual drawbacks of the network are overcome. The Q is raised from the usual 0.3 to something greater than 50. Further, the voltage follower acts as a buffer, providing a low output resistance; and the high input resistance of the LM102 makes it possible to use large resistance values in the "T" so that only small capacitors are required, even at low frequencies. The fast response of the follower allows the notch to be used at high frequencies. Neither the depth of the notch nor the frequency of the notch are changed when the follower is added.

Figure 1 shows a twin "T" network connected to an LM102 to form a high Q, 60 Hz notch filter.

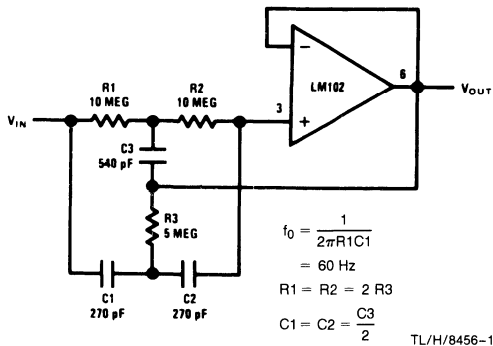


FIGURE 1. High Q Notch Filter

The junction of R_3 and C_3 , which is normally connected to ground, is bootstrapped to the output of the follower. Because the output of the follower is a very low impedance, neither the depth nor the frequency of the notch change; however, the Q is raised in proportion to the amount of signal fed back to R_3 and C_3 . Figure 2 shows the response of a normal twin "T" and the response with the follower added.

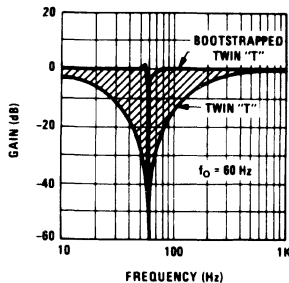


FIGURE 2. Response of High and Low Q Notch Filter

In applications where the rejected signal might deviate slightly from the null of the notch network, it is advantageous to lower the Q of the network. This insures some rejection over a wider range of input frequencies. Figure 3 shows a circuit where the Q may be varied from 0.3 to 50. A fraction of the output is fed back to R_3 and C_3 by a second voltage follower, and the notch Q is dependent on the amount of signal fed back. A second follower is necessary to drive the twin "T" from a low-resistance source so that the notch frequency and depth will not change with the potentiometer setting. Depending on the potentiometer setting, the circuit in Figure 3 will have a response that falls in the shaded area of Figure 2.

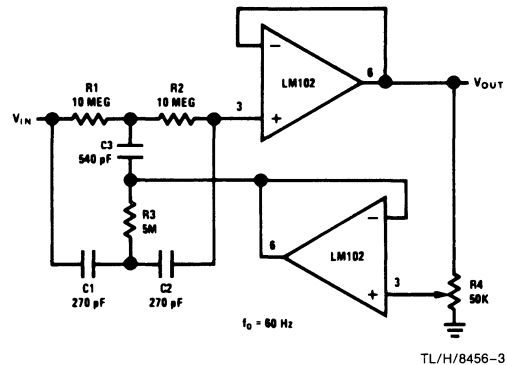


FIGURE 3. Adjustable Q Notch Filter

An interesting change in the high Q twin "T" occurs when components are not exactly matched in ratio. For example, an increase of 1 to 10 percent in the value of C_3 will raise the Q, while degrading the depth of the notch. If the value of C_3 is raised by 10 to 20 percent, the network provides voltage gain and acts as a tuned amplifier. A voltage gain of 400 was obtained during testing. Further increases in C_3 cause the circuit to oscillate, giving a clipped sine wave output.

The circuit is easy to use and only a few items need be considered for proper operation. To minimize notch frequency shift with temperature, silver mica, or polycarbonate, capacitors should be used with precision resistors. Notch depth depends on component match, therefore, 0.1 percent resistors and 1 percent capacitors are suggested to minimize the trimming needed for a 60 dB notch. To insure stability of the LM102, the power supplies should be bypassed near the integrated circuit package with .01 μ F disc capacitors.



Fast Voltage Comparators with Low Input Current

National Semiconductor
Linear Brief 6

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Monolithic voltage comparators are available today which are both fast and accurate. They can detect the height of a pulse with a 5 mV accuracy within 40 ns. However, these devices have relatively high input currents and low input impedances, which reduces their accuracy and speed when operating from high source resistances. This is probably a basic limitation since the input transistors of the integrated circuit must be operated at a relatively high current to get fast operation. Further, the circuit must be gold doped to reduce storage time, and this limits the current gain that can be obtained in the transistors. High gain transistors operating at low collector currents are necessary to get good input characteristics.

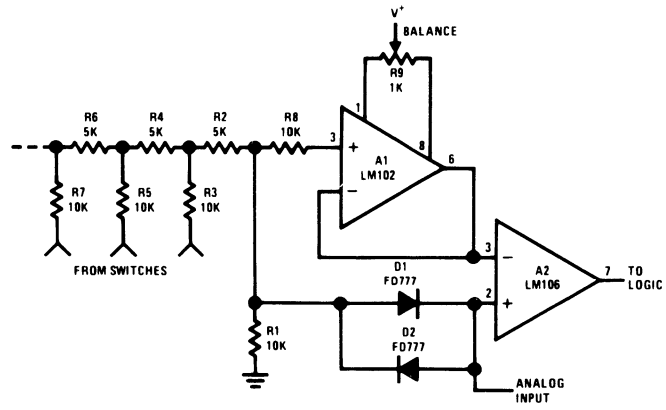
One way of overcoming this difficulty is to buffer the input of the comparator. A voltage follower is available which is

ideally suited for this job. This device, the LM102*, is both fast and has a low input current. It can reduce the effective input current of the comparator by more than three orders of magnitude without greatly reducing speed.

A comparator circuit for an A/D converter which uses this technique is shown in *Figure 1a*. An LM102 voltage follower buffers the output of a ladder network and drives one input of the comparator. The analog signal is fed to the other input of the comparator. It should come from a low impedance source such as the output of a signal processing amplifier, or another LM102 buffer amplifier.

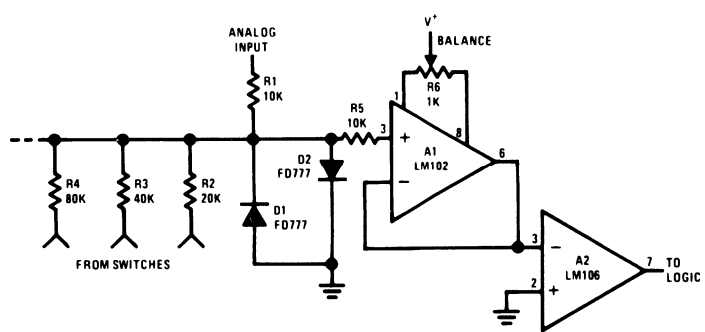
Clamp diodes, D₁ and D₂, are included to make the circuit faster. These diodes clamp the output of the ladder so that it is never more than 0.7V different from the analog input. This reduces the voltage excursion that the buffer must han-

*R. J. Widlar, "A Fast Integrated Voltage Follower", *National Semiconductor Corporation AN-8*, May, 1968.



a. using a ladder network

TL/H/8457-1



b. using a binary-weighted network

TL/H/8457-2

Figure 1. Comparator circuits for fast A/D converters

dle on the most significant bit and keeps it from slewing. If fast, low capacitance diodes are used, the signal to the comparator will stabilize approximately 200 ns after the most significant bit is switched in. This is about the same as the stabilization time of the ladder network alone, as its speed is limited by stray capacitances. The diodes also limit the voltage swing across the inputs of the comparator, increasing its operating speed and insuring that the device is not damaged by excessive differential input voltage.

The buffer reduces the loading on the ladder from 45 μ A to 20 nA, maximum, over a -55°C to $+125^{\circ}\text{C}$ temperature range. Hence, in most applications the input current of the buffer is totally insignificant. This low current will often permit the use of larger resistances in the ladder which simplifies design of the switches driving it.

It is possible to balance out the offset of the LM102 with an external 1 k Ω potentiometer, R_g . The adjustment range of this balance control is large enough so that it can be used to null out the offset of both the buffer and the comparator. A 10 k Ω resistor should be installed in series with the input to the LM102, as shown. This is required to make the short circuit protection of the device effective and to insure that it will not oscillate. This resistor should be located close to the integrated circuit.

A similar technique can be used with A/D converters employing a binary-weighted resistor network. This is shown in *Figure 1b*. The analog input is fed into a scaling resistor, R_1 . This resistor is selected so that the input voltage to the LM102 is zero when the output of the D/A network corresponds to the analog input voltage. Hence, if the D/A output is too low, the output of the LM106 will be a logical zero; and the output will change to a logical one as the D/A output exceeds the analog signal.

The analog signal must be obtained from a source impedance which is low by comparison to R_1 . This can be either another LM102 buffer or the output of the signal-processing amplifier. Clamp diodes, D_1 and D_2 , restrict the signal swing and speed up the circuit. They also limit the input signal seen by the LM106 to protect it from overloads. Operating speed can be increased even further by using silicon backward diodes (a degenerate tunnel diode) in place of the diodes shown, as they will clamp the signal swing to about 50 mV. The offset voltage of both the LM102 and the LM106 can be balanced out, if necessary, with R_6 .

The binary weighted network can be driven with single pole, single-throw switches. This will result in a change in the output resistance of the network when it switches, but circuit performance will not be affected because the input current of the LM102 is negligible. Hence, using the LM102 greatly simplifies switch design.

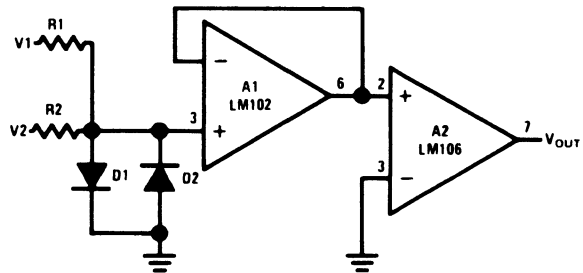
Although it is possible to use a 710 as the voltage comparator in these circuits, the LM106 offers several advantages. First, it can drive a fan out of 10 with standard, integrated DTL or TTL. It also has two strobe terminals available which disable the comparator and give a high output when either of the terminals is held at a logical zero. This adds logic

capability to the comparator in that it makes it equivalent to a 710 and a two-input NAND gate. If not needed, the strobe pins can be left unconnected without affecting performance. The voltage gain of the LM106 is about 45,000 which is 30 times higher than that of the 710. The increased gain reduces the error band in making a comparison. The LM106 will also operate from the same supply voltage as the LM102, and other operational amplifiers, for $\pm 12\text{V}$ supplies. However, it can also be operated from $\pm 15\text{V}$ supplies if a 3V zener diode is connected in series with the positive supply lead.

It is necessary to observe a few precautions when working with fast circuits operating from relatively high impedances. A good ground is necessary, and a ground plane is advisable. All the individual points in the circuit which are to be grounded, including bypass capacitors, should be returned separately to the same point on the ground so that voltages will not be developed across common lead inductance. The power supply leads of the integrated circuits should also be bypassed with low inductance 0.01 μF capacitors. These capacitors, preferably disc ceramic, should be installed with short leads and located close to the devices. Lastly, the output of the comparator should be shielded from the circuitry on the input of the buffer, as stray coupling can also cause oscillation.

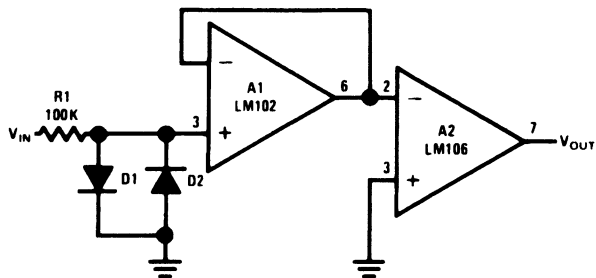
Although the circuits shown so far were designed for use in A/D converters, the same techniques apply to a number of other applications. *Figure 2* gives examples of circuits which can put stringent input current requirements on the comparator. The first is a comparator for signals of opposite polarity. Resistors (R_1 and R_2) are required to isolate the two signal sources. Frequently, these resistors must be relatively large so that the signal sources are not loaded. Hence, the input current of the comparator must be reduced to prevent inaccuracies. Another example is the zero-crossing detector in *Figure 2b*. When the input signal can exceed the common mode range of the comparator ($\pm 5\text{V}$ for the LM106), clamp diodes must be used. It is then necessary to isolate the comparator from the input with a relatively large resistance to prevent loading. Again, bias currents should be reduced. A third example, in *Figure 2c*, is a comparator with an ac coupled input. An LM106 will draw an input current which is twice the specified bias current when the signal is above the comparison threshold. Yet, it draws no current when the signal is below the threshold. This asymmetrical current drain will charge any coupling capacitor on the input and produce an error. This problem can be eliminated by using a buffer, as the input current will be both low and constant.

The foregoing has shown how two integrated circuits can be combined to provide state-of-the-art performance in both speed and input current. Equivalent results will probably not be achievable in a single circuit for some time, as the technologies required are not particularly compatible. Further, considering the low cost of monolithic circuits, approaches like this are certainly economical.



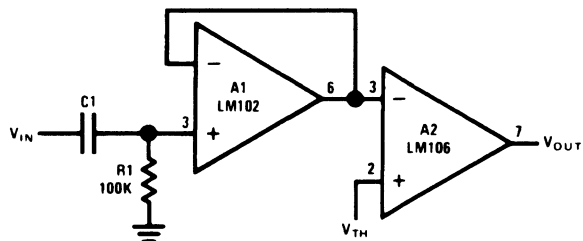
TL/H/8457-3

a. comparator for signals of opposite polarity



TL/H/8457-4

b. zero crossing detector



TL/H/8457-5

c. comparator for AC coupled signals

Figure 2. Applications requiring low input current comparators

Tracking Voltage Regulators

National Semiconductor
Linear Brief 7



Integrated circuit voltage regulators are available today which are economical and offer a high degree of performance. There are both positive and negative regulators capable of achieving better than 0.1% regulation under normal fluctuations in input supply and load. Due to production variations, the internal reference voltage in these regulators may vary as much as 10% from unit to unit. Normally, this causes no problems as most power supply circuits have an adjustment potentiometer which is varied to obtain the correct output voltage. In systems with more than one regulated output voltage, it is sometimes desirable to adjust all supplies with a single potentiometer. This results in savings by eliminating one or more potentiometers as well as eliminating the need to adjust the supplies individually.

Figure 1 shows a 5V and a 15V regulator with both outputs adjusted with a single potentiometer. Although the technique is not exact, the error is typically under 2%. As shown in Figure 1, the internal reference voltages for the LM105* regulators, available at pin 5, are tied together. This insures that both regulators operate with the same reference voltage. The lower resistors of the output divider, R_2 , are connected through a common adjustment potentiometer to ground. R_5 adjusts both regulators for variations in the 1.8V reference. Note that the wiper of R_5 is connected to one side of the potentiometer. If a rheostat connection were used, the arm might open circuit during adjustment, causing large transients on the output.

The calculations of resistor values for the output divider resistors are made with the consideration that the adjustment is not exact and that two regulators are adjusted. The bottom resistor of the divider, R_2 , is fixed at 2k. The top of the divider, R_1 , is then calculated for the output voltage using

1.6V as the reference voltage. To help compensate for the inaccuracies in the adjustment, output voltages are calculated slightly off from the desired values. For the 5 and 15V regulators, R_1 is calculated to give a 2% low output voltage on the 5V regulator and a 2% high output voltage on the 15V regulator.

$$R_1 = \frac{(V_{OUT} - 1.6V) 2000\Omega}{1.6V}$$

R_5 will now adjust both regulators to within 2% of the desired output for reference variations from 1.6V to 2.0V. From the previous calculations, a 1.6V reference yields outputs of 4.9V and 15.3V. If the reference is 2.0V, R_5 is adjusted to 324 Ω and the output voltages are 5.1V and 14.9V. If the reference is near the typical value of 1.8V, both outputs are within 1% of nominal.

These calculations do not account for resistor inaccuracies. If 1% resistors are used there is an additional worst case error of 2% for each regulator. Resistor errors are inherent in any type of tracking regulator system, even if the adjustment is theoretically exact.

Actually, any number of regulators may be connected to a single adjustment resistor. The adjustment accuracy of this technique depends on the output voltage differences among the regulators. The previous example was a severe difference, and had only 2% accuracy. With close output voltages, such as 12V and 15V, the error is much smaller. The 12V regulator is calculated to 1/2% low and 15V regulator 1/2% high with the 1.6V reference. Both regulators are then within 1/2% for reference variations of 1.6 to 2.0 volts. This adjustment method is, of course, exact if two regulators have the same output.

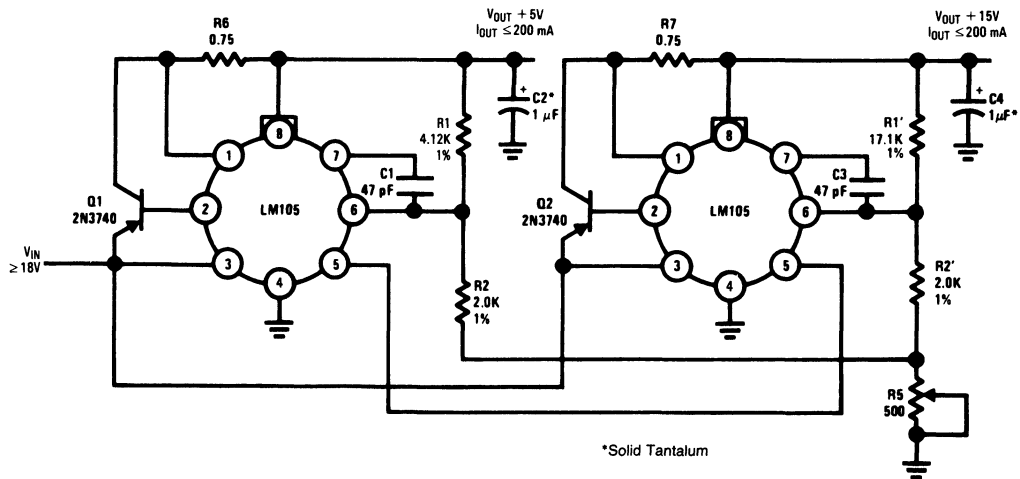


FIGURE 1. Tracking Positive Regulators

TL/H/8458-1

*R. J. Widlar, "The LM105—An Improved Positive Regulator," National Semiconductor Corporation, AN-23, January, 1969.

Using a negative regulator to track a positive regulator is a somewhat easier task. An inverting operational amplifier may be used to provide a negative output voltage while using a positive voltage as a reference. The LM104 negative regulator is easily adapted for use as an inverting amplifier and provides several advantages over conventional operational amplifiers. It is designed to drive boost transistors for higher output current as well as providing a convenient method of current limiting the output. Further, the frequency compensation used on the LM104 is optimized for transient response to line and load changes. Figure 2 shows tracking $\pm 15V$ regulators.

Operation is most easily understood by referring to the functional schematic of the LM104 in Figure 3. The non-inverting input of the internal amplifier, pin 1, is connected to ground.

The positive 15V reference is connected through an internal 15 k Ω input resistor, R₁₆, to the inverting input. Feedback

resistor, R₁₅, is also 15 k Ω . This forms a unity gain inverting amplifier with a negative output voltage equal to the positive input voltage. The 15 k Ω resistors in the LM104 are typically matched to 1%. This means that the output of both regulators may be adjusted with 1% accuracy by changing R₁ in Figure 2.

The LM104 may also be used with inverting gain for negative output voltages greater than the positive reference voltage. Figure 4 shows a circuit where the $-15V$ supply tracks a $+5V$ supply. In this configuration the non-inverting input is not grounded, but tied to divider, R₅, R₆, between the negative output and ground. The output voltage equals

$$V_{OUT} = V^+ \left[\frac{R_5 + R_6}{R_6 - R_5} \right]$$

where V⁺ is the positive reference.

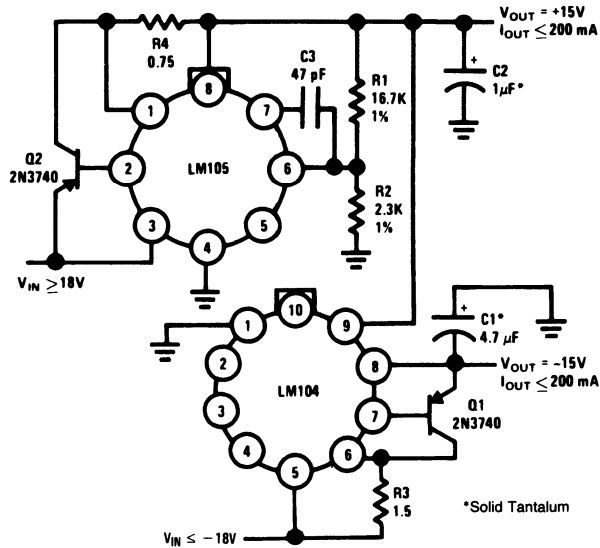


FIGURE 2. Tracking Positive and Negative Regulators

TL/H/8458-2

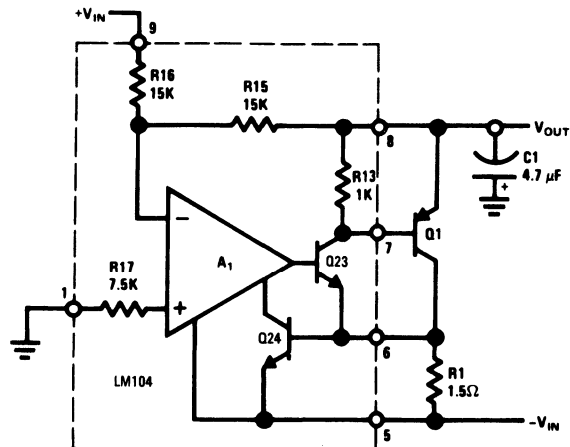
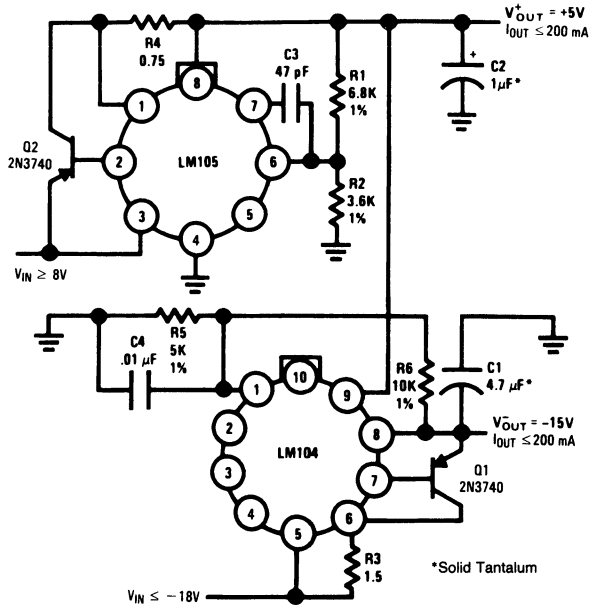


FIGURE 3. Functional Diagram of the LM104 Used as an Amplifier

TL/H/8458-3



$$V_{-OUT} = -V_{+OUT} \left[\frac{R_5 + R_6}{R_6 - R_5} \right]$$

TL/H/8458-4

FIGURE 4. Tracking Regulators with Different Output Voltages

The line regulation and temperature drift are determined primarily by the positive reference, with the negative output tracking. The reference must be a low impedance source, such as an LM105 regulator, to insure that current drawn by pin 9 of the LM104 does not affect the reference voltage. Since the LM104 is connected to a positive voltage instead of ground, it sees a total voltage equal to the sum of the unregulated negative input and the positive reference voltage. This reduces the maximum unregulated negative input voltage allowable, and should be considered during design. If the negative output voltage must be less than the positive reference or the decrease in maximum unregulated input voltage cannot be tolerated, an alternate method of con-

structing tracking regulators is given elsewhere[†]. Of course, many negative regulators may be slaved to a single positive regulator.

Using standard linear integrated circuits, multiple output positive and negative supplies may be adjusted to within 2% or less by a single resistor. Although the absolute output is not exact, the regulation accuracy is still within 0.1%. These techniques can result in savings by the elimination of both time and materials when used.

REFERENCES

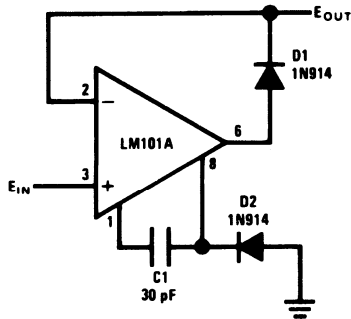
[†]R. J. Widlar, "Designs for Negative Regulators," National Semiconductor Corporation, AN-21, December, 1968.

Precision AC/DC Converters



Although semiconductor diodes available today are close to "ideal" devices, they have severe limitations in low level applications. Silicon diodes have a 0.6V threshold which must be overcome before appreciable conduction occurs. By placing the diode in the feedback loop of an operational amplifier, the threshold voltage is divided by the open loop gain of the amplifier. With the threshold virtually eliminated, it is possible to rectify millivolt signals.

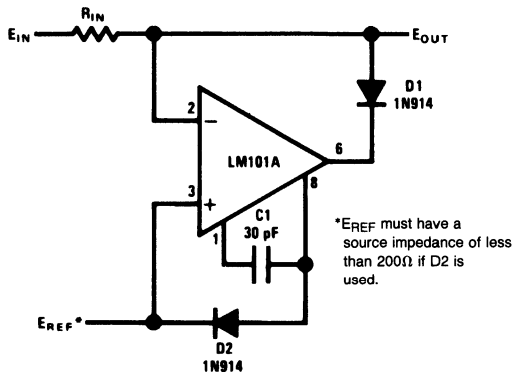
Figure 1 shows the simplest configuration for eliminating diode threshold potential. If the voltage at the non-inverting input of the amplifier is positive, the output of the LM101A



TL/H/8459-1

FIGURE 1. Precision Diode

swings positive. When the amplifier output swings 0.6V positive, D_1 becomes forward biased; and negative feedback through D_1 forces the inverting input to follow the non-inverting input. Therefore, the circuit acts as a voltage follower for positive signals. When the input swings negative, the output swings negative and D_1 is cut off. With D_1 cut off no current flows in the load except the 30 nA bias current of the LM101A. The conduction threshold is very small since less than $100 \mu\text{V}$ change at the input will cause the output of the LM101A to swing from negative to positive.



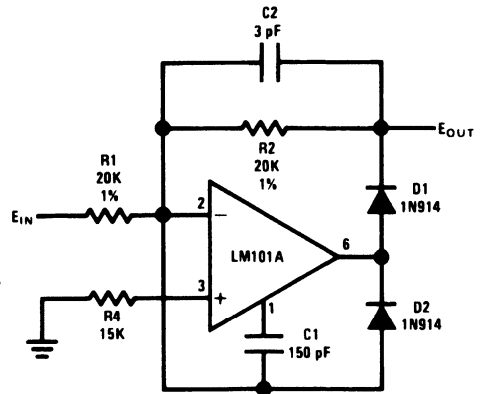
TL/H/8459-2

FIGURE 2. Precision Clamp

A useful variation of this circuit is a precision clamp, as is shown in Figure 2. In this circuit the output is precisely clamped from going more positive than the reference voltage. When E_{IN} is more positive than E_{REF} , the LM101A functions as a summing amplifier with the feedback loop closed through D_1 . Neglecting offsets, negative feedback keeps the summing node, and therefore the output, within $100 \mu\text{V}$ of the voltage at the non-inverting input. When E_{IN} is about $100 \mu\text{V}$ more negative than E_{REF} , the output swings positive, reverse biasing D_1 . Since D_1 now prevents feedback from controlling the voltage at the inverting input, no clamping action is obtained. On both of the circuits in Figures 1 and 2 an output clamp diode is added at pin 8 to help speed response. The clamp prevents the operational amplifier from saturating when D_1 is reverse biased.

When D_1 is reverse biased in either circuit, a large differential voltage may appear between the inputs of the LM101A. This is necessary for proper operation and does no damage since the LM101A is designed to withstand large input voltages. These circuits will not work with amplifiers protected with back to back diodes across the inputs. Diode protection conducts when the differential input voltage exceeds 0.6V and would connect the input and output together. Also, unprotected devices such as the LM709, are damaged by large differential input signals.

The circuits in Figures 1 and 2 are relatively slow. Since there is 100% feedback for positive input signals, it is necessary to use unity gain frequency compensation. Also, when D_1 is reverse biased, the feedback loop around the amplifier is opened and the input stage saturates. Both of these conditions cause errors to appear when the input frequency exceeds 1.5 kHz. A high performance precision half wave rectifier is shown in Figure 3. This circuit will provide rectification with 1% accuracy at frequencies from dc to 100 kHz. Further, it is easy to extend the operation to full wave rectification for precision AC/DC converters.



TL/H/8459-3

FIGURE 3. Fast Half Wave Rectifier

This precision rectifier functions somewhat differently from the circuit in *Figure 1*. The input signal is applied through R_1 to the summing node of an inverting operational amplifier. When the signal is negative, D_1 is forward biased and develops an output signal across R_2 . As with any inverting amplifier, the gain is R_2/R_1 . When the signal goes positive, D_1 is non-conducting and there is no output. However, a negative feedback path is provided by D_2 . The path through D_2 reduces the negative output swing to $-0.7V$, and prevents the amplifier from saturating.

Since* the LM101A is used as an inverting amplifier, feed-forward compensation can be used. Feedforward compensation increases the slew rate to $10 V/\mu s$ and reduces the gain error at high frequencies. This compensation allows the half wave rectifier to operate at higher frequencies than the previous circuits with no loss in accuracy.

The addition of a second amplifier converts the half wave rectifier to a full wave rectifier. As is shown in *Figure 4*, the half wave rectifier is connected to inverting amplifier A_2 . A_2 sums the half wave rectified signal and the input signal to provide a full wave output. For negative input signals the output of A_1 is zero and no current flows through R_3 . Neglecting for the moment C_2 , the output of A_2 is $-\frac{R_7}{R_6} E_{IN}$.

For positive input signals, A_2 sums the currents through R_3 and R_6 ; and

$$E_{OUT} = R_7 \left[\frac{E_{IN}}{R_3} - \frac{E_{IN}}{R_6} \right]$$

If R_3 is $\frac{1}{2} R_6$, the output is $\frac{R_7}{R_6} E_{IN}$. Hence, the output is always the absolute value of the input.

Filtering, or averaging, to obtain a pure dc output is very easy to do. A capacitor, C_2 , placed across R_7 rolls off the frequency response of A_2 to give an output equal to the average value of the input. The filter time constant is $R_7 C_2$, and must be much greater than the maximum period of the input signal. For the values given in *Figure 4*, the time constant is about 2.0 seconds. This converter has better than 1% conversion accuracy to above 100 kHz and less than 1% ripple at 20 Hz. The output is calibrated to read the rms value of a sine wave input.

As with any high frequency circuit some care must be taken during construction. Leads should be kept short to avoid stray capacitance and power supplies bypassed with $0.01 \mu F$ disc ceramic capacitors. Capacitive loading of the fast rectifier circuits must be less than 100 pF or decoupling becomes necessary. The diodes should be reasonably fast and film type resistors used. Also, the amplifiers must have low bias currents.

REFERENCES

*R. C. Dobkin, "Feedforward Compensation Speeds Op Amp," *National Semiconductor Corporation, LB-2*, March, 1969.

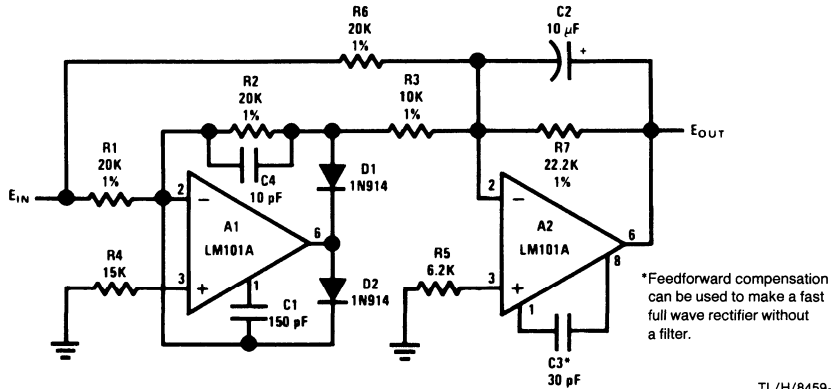


FIGURE 4. Precision AC to DC Converter

TL/H/8459-4

Universal Balancing Techniques



IC op amps are widely accepted as a universal analog component. Although the circuit designs may vary, most devices are functionally interchangeable. However, offset voltage balancing remains a personality trait of the particular amplifier design. The techniques shown here allow offset voltage balancing without regard to the internal circuitry of the amplifier.

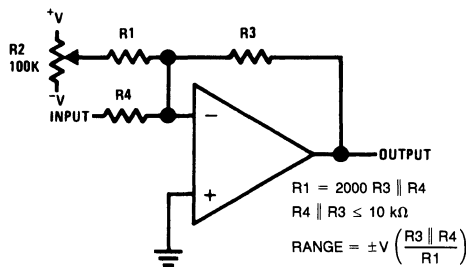


FIGURE 1. Offset Voltage Adjustment for Inverting Amplifiers Using 10 kΩ Source Resistance or Less

The circuit shown in *Figure 1* is used to balance out the offset voltage of inverting amplifiers having a source resistance of 10 kΩ or less. A small current is injected into the summing node of the amplifier through R₁. Since R₁ is 2000 times as large as the source resistance the voltage at the arm of the pot is attenuated by a factor of 2000 at the summing node. With the values given and ±15V supplies the output may be zeroed for offset voltages up to ±7.5 mV.

If the value of the source resistance is much larger than 10 kΩ, the resistance needed for R₁ becomes too large. In this case it is much easier to balance out the offset by supplying a small voltage at the non-inverting input of the amplifier. *Figure 2* shows such a scheme. Resistors R₁ and R₂ divide the voltage at the arm of the pot to supply a ±7.5 mV adjustment range with ±15V supplies.

This adjustment method is also useful when the feedback element is a capacitor or non-linear device.

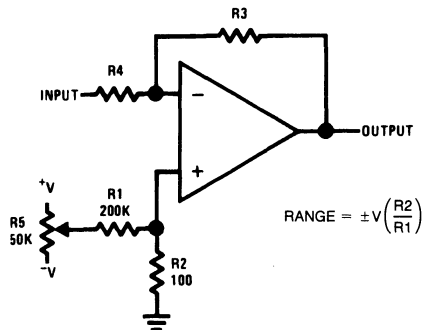


FIGURE 2. Offset Voltage Adjustment for Inverting Amplifiers Using Any Type of Feedback Element

This technique of supplying a small voltage effectively in series with the input is also used for adjusting non-inverting amplifiers. As is shown in *Figure 3*, divider R₁, R₂ reduces the voltage at the arm of the pot to ±7.5 mV for offset adjustment. Since R₂ appears in series with R₄, R₂ should be considered when calculating the gain. If R₄ is greater than 10 kΩ the error due to R₂ is less than 1%.

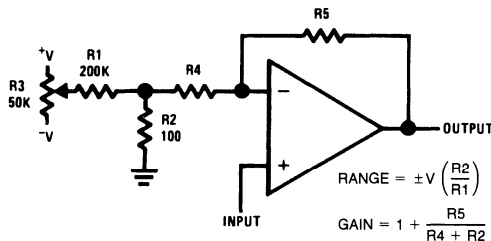


FIGURE 3. Offset Voltage Adjustment for Non-Inverting Amplifiers

A voltage follower may be balanced by the technique shown in *Figure 4*. R_1 injects a current which produces a voltage drop across R_3 to cancel the offset voltage. The addition of the adjustment resistors causes a gain error, increasing the gain by 0.05%. This small error usually causes no problem. The adjustment circuit essentially causes the offset voltage to appear at full output, rather than at low output levels, where it is a large percentage error.

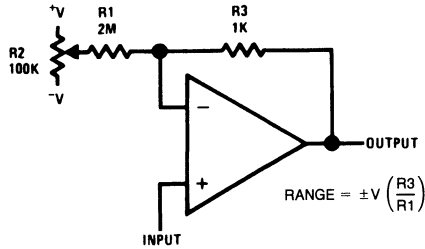


FIGURE 4. Offset Voltage Adjustment for Voltage Followers

Differential amplifiers are somewhat more difficult to balance. The offset adjustment used for a differential amplifier can degrade the common mode rejection ratio. *Figure 5* shows an adjustment circuit which has minimal effect on the common mode rejection. The voltage at the arm of the pot is divided by R_4 and R_5 to supply an offset correction of ± 7.5 mV. R_4 and R_5 are chosen such that the common mode rejection ratio is limited by the amplifier for values of R_3 greater than 1 k Ω . If R_3 is less than 1k the shunting of R_4 by R_5 must be considered when choosing the value of R_3 .

TL/H/8460-4

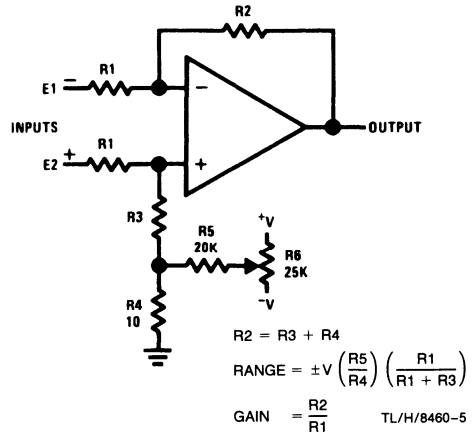


FIGURE 5. Offset Voltage Adjustment for Differential Amplifiers

The techniques described for balancing offset voltage at the input of the amplifier offer two main advantages: First, they are universally applicable to all operational amplifiers and allow device interchangeability with no modifications to the balance circuitry. Second, they permit balancing without interfering with the internal circuitry of the amplifier. The electrical parameters of the amplifiers are tested and guaranteed without balancing. Although it doesn't usually happen, balancing could degrade performance.

$$R_2 = R_3 + R_4$$

$$\text{RANGE} = \pm V \left(\frac{R_5}{R_4} \right) \left(\frac{R_1}{R_1 + R_3} \right)$$

$$\text{GAIN} = \frac{R_2}{R_1} \quad \text{TL/H/8460-5}$$

IC Regulators Simplify Power Supply Design

National Semiconductor
Linear Brief 10



LB-10

Although power supply requirements vary, IC voltage regulators can fulfill the majority of needs. Power supplies designed with ICs can give predictable regulation better than 0.1% with a minimum of engineering effort. Output voltages between 0 and 40V at currents of 10A are easily achieved. Further, with a minimum of changes, a single regulator circuit can be used for a wide variety of output voltages and currents.

A basic 200 mA positive regulator circuit is shown in *Figure 7*. The LM105¹ contains the voltage reference and control circuitry while the external components set the output

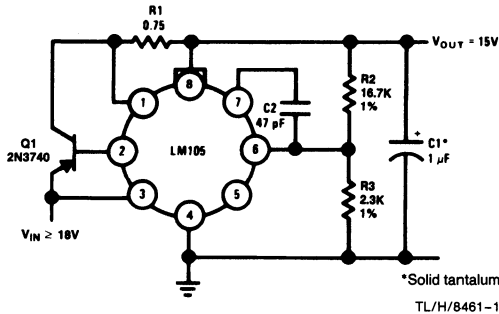


FIGURE 1. 200 mA Positive Regulator

voltage, current limit and increase power handling capacity of the IC. The output voltage is set by R₂ and R₃. A fraction of the output voltage is compared by an error amplifier with an internal 1.8V reference. Any error is amplified and used to drive the 2N3740 power transistor. Since the open loop gain is large, there is little error and a high degree of regulation.

Current limiting is set by R₁. The voltage drop across R₁ is applied to the emitter base junction of a transistor in the IC. When the transistor is turned on, it removes drive from the series pass transistor; and the regulator output exhibits a constant current characteristic. Since the turn on voltage of a transistor is temperature dependent, so is the current limit. The current limit sense voltage is about 0.4V at 25°C decreasing linearly to 0.3V at 125°C. Therefore, the current limit resistor must be chosen to provide adequate output current at the maximum operating temperature.

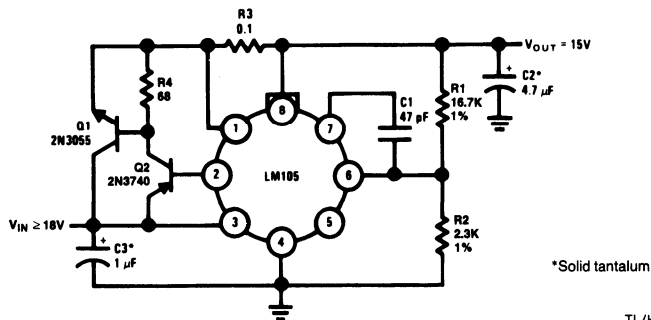


FIGURE 3a. 2A Positive Regulator

To regulate negative voltages, the circuit in *Figure 2* is used. An LM104 contains the voltage reference and control circuitry while an external transistor is used to increase the power handling capacity. A reference voltage is generated by driving a constant current, determined by R₁, through R₂. The voltage across this resistor is fed into an error amplifier. The error amplifier controls the output voltage at twice the voltage across R₂. The output voltage is resistor programmable with R₂ and adjustable down to zero.

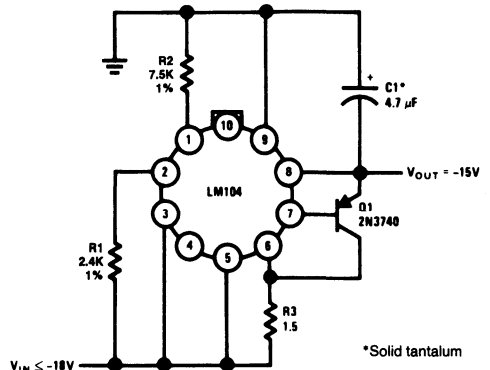
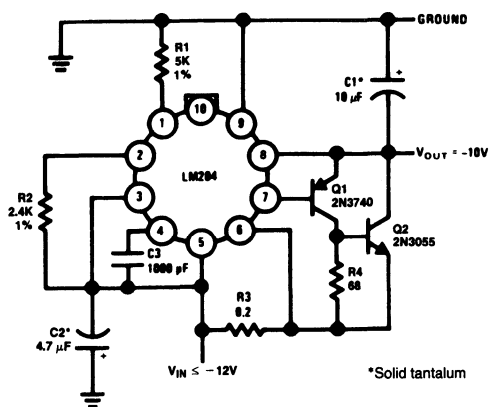


FIGURE 2. 200 mA Negative Regulator

Current limit in the LM104 is similar to the LM105. Voltage across R₃ turns on an internal transistor that decreases drive to the output transistors. This current limit sense voltage is also temperature dependent, decreasing from 0.65V at 25°C to 0.45V at 125°C.

Boosting the available output current from 200 mA is relatively simple. *Figure 3* shows positive and negative 2A regulators. An additional power transistor increases the current handling capability of the regulator. Adding the boost transistors increases the output current without increasing the minimum input-output voltage differential. The minimum differential will be 2 to 3V, depending on the drive current required from the integrated circuit and operating temperature. Low input-output voltage differential allows more efficient regulation.



TL/H/8461-4

FIGURE 3b. 2A Negative Regulator

Although the regulators are relatively simple, some precautions must be taken to eliminate possible problems. First, when the regulator is used with boost transistors, a solid tantalum output capacitor is needed. Unlike electrolytics, solid tantalum capacitors have low internal impedance at high frequencies. This suppresses possible high frequency minor loop oscillations as well as providing low output impedance at high frequency. Also, for the LM104, the output capacitor frequency compensates the regulator and must have good frequency characteristics.

The power transistors recommended are single-diffused, wide-base devices. These devices have fewer oscillation problems than double-diffused, planar transistors. Also, they seem less prone to failure under overload conditions. Of course, like the power transistors in any regulator, adequate heat sinking is necessary. The heat sink should keep the transistor junction temperature at an acceptable level for worst case conditions of maximum input voltage, maximum ambient temperature and shorted output. By far, the major cause of regulator failures is inadequate heat sinking.

Good construction techniques are also important for regulator performance. If proper care is not taken, ground loop errors and lead resistance drops can easily become greater than regulator errors. For example, 0.05" wide, 2 oz. printed circuit conductor has a resistance of about 0.007 Ω per inch.

For a 200 mA, 15V regulator, ten inches of conductor would decrease the regulation by a factor of 2.

Ground loops are worst yet, since voltage drops can be amplified and appear at the regulator's output. In Figure 3, voltage drops between Pin 4 of the LM105 and the bottom of R₃ are amplified by the ratio of R₂/R₃ and appear at the output.

When the regulator is powered from ac that is rectified and filtered, current flowing in the filter can sometimes cause an unusual ground loop problem. For capacitor input filters, the peak charging current is many times the average load current. Even a few milliohms of resistance can cause appreciable voltage drop during the peak of the charging. When the charging current produces a voltage drop between R₃ and Pin 4 of the LM105, it appears as excessive ripple on the output of the regulator.

Of course, single point grounding eliminates these problems, but this is not always possible. Usually it is sufficient to insure that load current does not generate a voltage drop between the ground side of the voltage setting resistor and the ground of the IC.

In most cases, short circuit protection is the only fault protection needed. However, for some regulator circuits, such as positive and negative regulators used together, additional protection is necessary. If the positive and negative supplies are shorted together, it is possible to cause the output voltage of one of the supplies to reverse, blowing the IC. This is especially true if the current capabilities are different, such as a 200 mA negative supply and a 2A positive supply. A clamp diode between the output and ground of each supply will prevent such polarity reversals. Also, clamp diodes should be used to prevent input polarity reversal and input-output voltage differential reversal.

The use of ICs in regulator circuits can enhance power supply performance while minimizing cost and engineering time. Since only one IC is needed for a wide range of outputs, the part cost, board space and purchasing problems are less when compared to discrete designs. Also engineering time is saved since typical and worst case performance data, as well as application data, is available from the manufacturer before design is begun.

REFERENCES

1. R.J. Widlar, "An Improved Positive Regulator," *National Semiconductor AN-23*, January, 1969.
2. R.J. Widlar, "Designs for Negative Regulators," *National Semiconductor AN-21*, October, 1968.

The LM110 An Improved IC Voltage Follower

National Semiconductor
Linear Brief 11



LB-11

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There are quite a few applications where op amps are used as voltage followers. These include sample and hold circuits and active filters as well as general purpose buffers for transducers or other high-impedance signal sources. The general usefulness of such an amplifier is particularly enhanced if it is both fast and has a low input bias current. High speed permits including the buffer in the signal path or within a feedback loop without significantly affecting response or stability. Low input current prevents loading of high impedance sources, which is the reason for using a buffer in the first place.

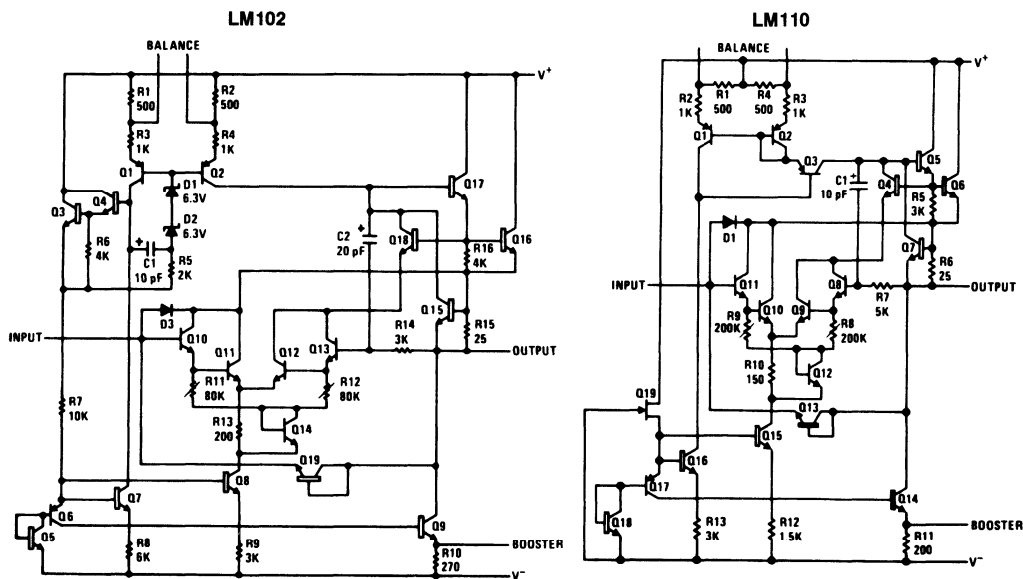
The LM102, introduced in 1967, was designed specifically as a voltage follower. Therefore, it was possible to optimize performance so that it worked better than general purpose IC amplifiers in this application. This was particularly true with respect to obtaining low input currents along with high-speed operation.

One secret of the LM102's performance is that followers do not require level shifting. Hence, lateral PNP's can be eliminated from the gain path. This has been the most significant

limitation on the frequency response of general purpose amplifiers. Secondly, it was the first IC to use super-gain transistors. With these devices, high speed operation can be realized along with low input currents.

The LM110 is a voltage follower that has been designed to supersede the LM102. It is considerably more flexible in its application and offers substantially improved performance. In particular, the LM110 has lower offset-voltage drift, input current and noise. Further, it is faster, less prone to oscillations and operates over a wider range of supply voltages.

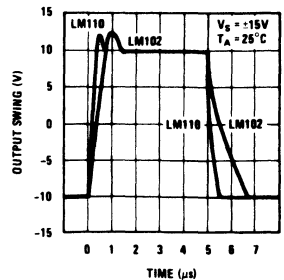
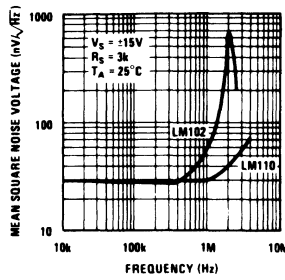
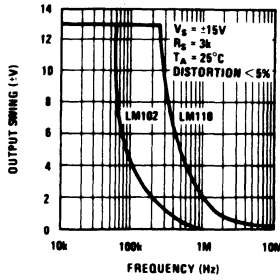
The advantages of the LM110 over the LM102 are described by the following curves. Improvements not included are increased output swing under load, larger small-signal bandwidth, and elimination of oscillations with low-impedance sources. The performance of these devices is also compared with general-purpose op amps in Tables I and II. The advantages of optimizing an IC for this particular slot are clearly demonstrated. Lastly, some typical applications for voltage followers with the performance capability of the LM110 are given.



TL/H/8462-1

TL/H/8462-2

Biggest design difference between the LM102 and LM110 is the elimination of the zener diodes (D1 and D2) in the biasing circuit. This reduces noise and permits operation at low supply voltages.



TL/H/8462-3

Power bandwidth of the LM110 is five times larger than the LM102.

Eliminating zeners reduces typical high frequency noise by nearly a factor of 10. Worst case noise is reduced even more. High frequency noise of LM102 has caused problems when it was included inside feedback loop with other IC op amps.

Large signal pulse response shows 40V/μs slew for LM110 and 10V/μs for LM102. Leading edge overshoot on LM110 is virtually eliminated, so external clamp diode frequently required on the LM102 is not needed.

Table I. Comparing performance of military grade IC op amps in the voltage-follower connection

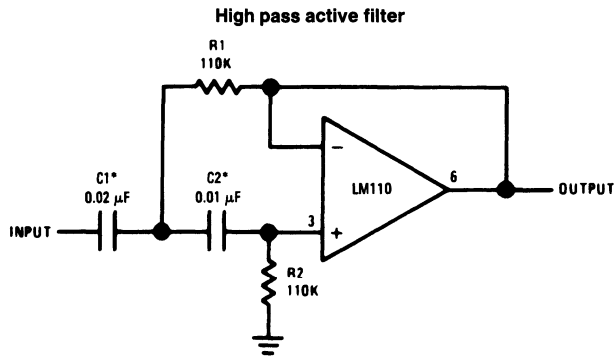
Device	Offset** Voltage (mV)	Bias** Current (nA)	Slew† Rate (V/μs)	Bandwidth† (MHz)	Supply* Current (mA)
LM110	6.0	10	40	20	5.5
LM102	7.5	100	10	10	5.5
MC1556	6.0	30	2.5	1	1.5
μA715	7.5	4000	20	10	7.0
LM108	3.0	3	0.3	1	0.6
LM108A	1.0	3	0.3	1	0.6
LM101A	3.0	100	0.6	1	3.0
μA741	6.0	1500	0.6	1	3.0

**Maximum for -55°C ≤ T_A ≤ 125°C
*Maximum at 25°C
†Typical at 25°C

Table II. Comparison of commercial grade devices

Device	Offset* Voltage (mV)	Bias* Current (nA)	Slew† Rate (V/μs)	Bandwidth† (MHz)	Supply* Current (mA)
LM310	7.5	7.0	40	20	5.5
LM302	15	30	20	10	5.5
MC1456	10	30	2.5	1	1.5
μA715C	7.5	1500	20	10	10
LM308	7.5	7.0	0.3	1	0.8
LM308A	0.5	7.0	0.3	1	0.8
LM301A	7.5	250	0.6	1	3.0
μA741C	6.0	500	0.6	1	3.0

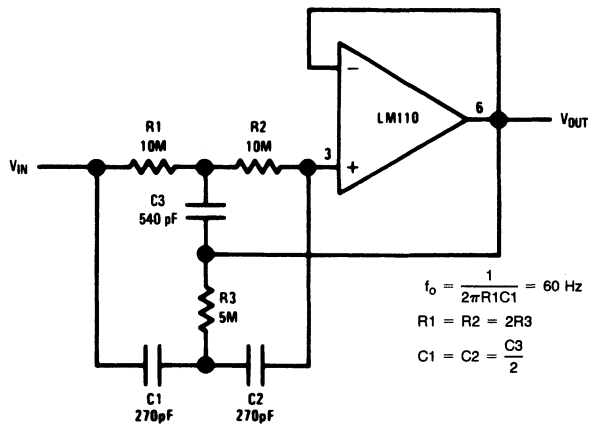
*Maximum at 25°C
†Typical at 25°C



*Values are for 100 Hz cutoff. Use metallized polycarbonate capacitors for good temperature stability

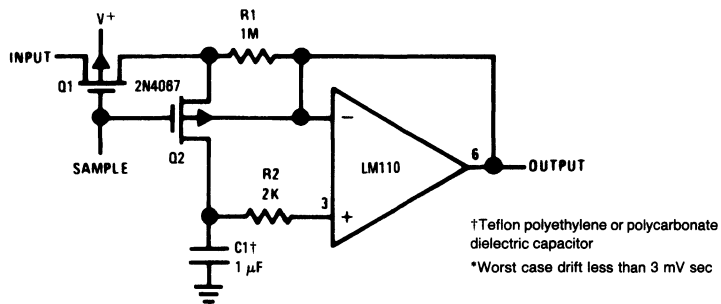
TL/H/8462-4

High Q Notch Filter



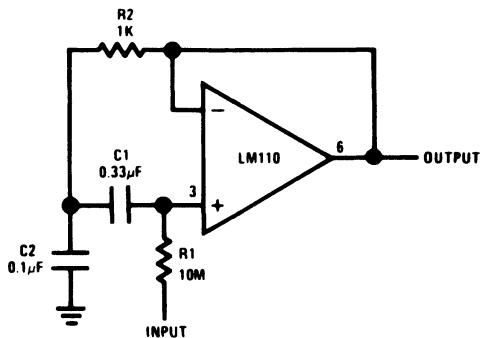
TL/H/8462-5

Low Drift Sample and Hold*



TL/H/8462-6

Bandpass Filter



TL/H/8462-7

An IC Voltage Comparator for High Impedance Circuitry

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The IC voltage comparators available in the past have been designed primarily for low voltage, high speed operation. As a result, these devices have high input error currents, which limit their usefulness in high impedance circuitry. An IC is described here that drastically reduces these error currents, with only a moderate decrease in speed.

This new comparator is considerably more flexible than the older devices. Not only will it drive RTL, DTL and TTL logic; but also it can interface with MOS logic and FET analog switches. It operates from standard $\pm 15V$ op amp supplies and can switch 50V, 50 mA loads, making it useful as a driver for relays, lamps or light-emitting diodes. A unique output stage enables it to drive loads referred to either supply or ground and provide ground isolation between the comparator inputs and the load.

Another useful feature of the circuit is that it can be powered from a single 5V supply and drive DTL or TTL integrated circuits. This enables the designer to perform linear functions on a digital-circuit card without using extra supplies. It can, for example, be used as a low-level photodiode detector, a zero crossing detector for magnetic transducers, an interface for high-level logic or a precision multivibrator.

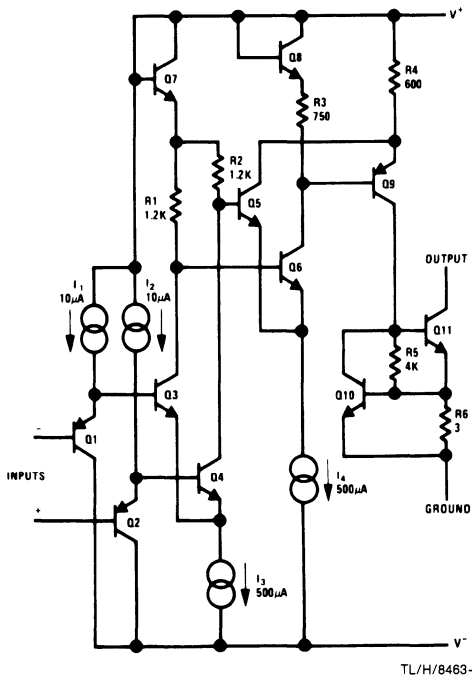


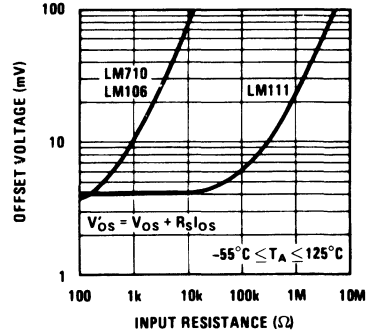
Figure 1. Simplified schematic of the LM111

National Semiconductor
Linear Brief 12



Figure 1 shows a simplified schematic of this versatile comparator. PNP transistors buffer the differential input stage to get low input currents without sacrificing speed. Because the emitter base breakdown voltage of these PNPs is typically 70V, they can also withstand a large differential input voltage. The PNPs drive a standard differential stage. The output of this stage is further amplified by the Q_5 - Q_6 pair. This feeds a lateral PNP, Q_9 , that provides additional gain and drives the output stage.

The output transistor is Q_{11} which is driven by the level shifting PNP. Current limiting is provided by R_6 and Q_{10} to protect the circuit from intermittent shorts. Both the output and the ground lead are isolated from other points within the circuit, so either can be used as the output. The V^- terminal can also be tied to ground to run the circuit from a single supply. The comparator will work in any configuration as long as the ground terminal is at a potential somewhere between the supply voltages. The output terminal, however, can go above the positive supply as long as the breakdown voltage of Q_{11} is not exceeded.



TL/H/8463-2

Figure 2. Illustrating the influence of source resistance on worst case, equivalent input offset voltage

Figure 2 shows how the reduced error currents of the LM111 improve circuit performance. With the LM710 or LM106, the offset voltage is degraded for source resistances above 200 Ω . The LM111, however, works well with source resistances in excess of 30 k Ω . Figure 2 applies for equal source resistances on the two inputs. If they are unequal, the degradation will become pronounced at lower resistance levels.

Table I gives the important electrical characteristics of the LM111 and compares them with the specifications of older ICs.

A few, typical applications of the LM111 are illustrated in Figure 3. The first is a zero crossing detector driving a MOS

Table I. Comparing the LM111 with earlier IC comparators. Values given are worst case over a -55°C to $+125^{\circ}\text{C}$ temperature range, except as noted.

Parameter	LM111	LM106	LM710	Units
Input Offset Voltage	4	3	3	mV
Input Offset Current	0.02	7	7	μA
Input Bias Current	0.15	45	45	μA
Common Mode Range	± 14	± 5	± 5	V
Differential Input Voltage Range	± 30	± 5	± 5	V
Voltage Gain†	200	40	1.7	V/mV
Response Time†	200	40	40	ns
Output Drive Voltage	50	24	2.5	V
Output Drive Current	50	100	1.6	mA
Fan Out (DTL/TTL)	8	16	1	
Power Consumption	80	145	160	mW

†Typical at 25°C .

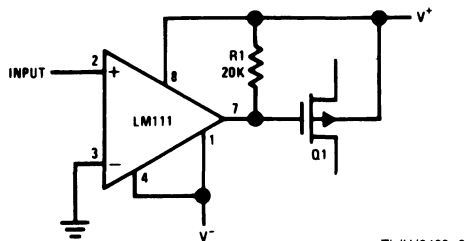
analog switch. The ground terminal of the IC is connected to V^- ; hence, with $\pm 15\text{V}$ supplies, the signal swing delivered to the gate of Q_1 is also $\pm 15\text{V}$. This type of circuit is useful where the gain or feedback configuration of an op amp circuit must be changed at some precisely-determined signal level. Incidentally, it is a simple matter to modify the circuit to work with junction FETs.

The second circuit is a zero crossing detector for a magnetic pickup such as a magnetometer or shaft-position pickoff. It delivers the output signal directly to DTL or TTL logic circuits and operates from the 5V logic supply. The resistive divider, R_1 and R_2 , biases the inputs 0.5V above ground, within the common mode range of the device. An optional offset balancing circuit, R_3 and R_4 , is included.

The next circuit shows a comparator for a low-level photodiode operating with MOS logic. The output changes state when the diode current reaches $1\ \mu\text{A}$. At the switching point, the voltage across the photodiode is nearly zero, so its leakage current does not cause an error. The output switches between ground and -10V , driving the data inputs of MOS logic directly.

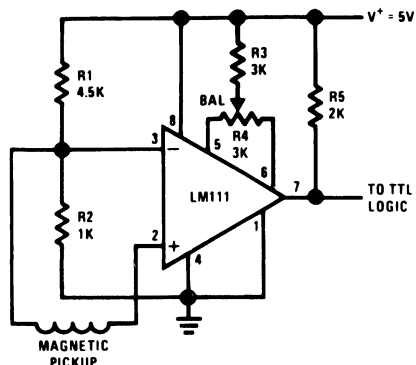
The last circuit shows how a ground-referred load is driven from the ground terminal of the LM111. The input polarity is reversed because the ground terminal is used as the output. An incandescent lamp, which is the load here, has a cold resistance eight times lower than it is during normal operation. This produces a large inrush current, when it is switched on, that can damage the switch. However, the current limiting of the LM111 holds this current to a safe value.

The applications described above show that the output-circuit flexibility and wide supply-voltage range of the LM111 opens up new fields for IC comparators. Further, its low error currents permit its use in circuits with impedance levels above $1\ \text{k}\Omega$. Although slower than older devices, it is more than an order of magnitude faster than op amps used as comparators.



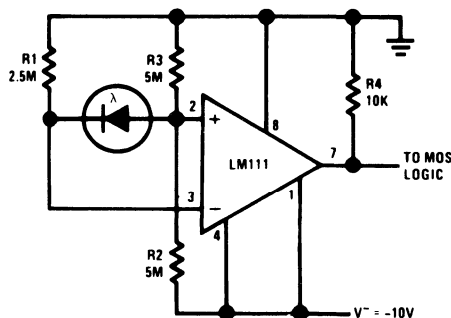
TL/H/8463-3

a. zero crossing detector driving analog switch



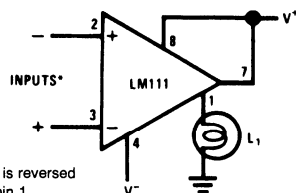
TL/H/8463-4

b. detector for magnetic transducer



TL/H/8463-5

c. comparator for low level photodiode



*Input polarity is reversed when using pin 1 as output.

TL/H/8463-6

d. driving ground-referred load

Figure 3. Typical applications of the LM111

The LM111 has the same pin configuration as the LM710 and LM106. It is interchangeable with these devices in applications where speed is not of prime concern.

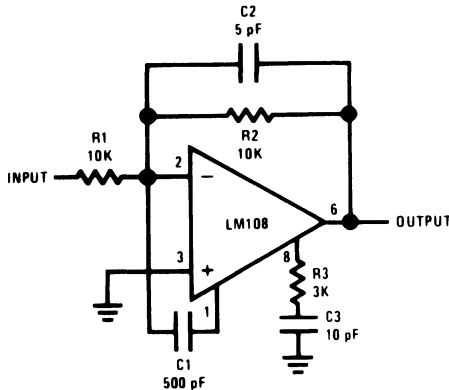
Speed Up the LM108 Feedforward Compensation

National Semiconductor
Linear Brief 14



Feedforward frequency compensation of operational amplifiers can provide a significant increase in slew rate and bandwidth over standard lag compensation. When feedforward compensation is applied to the LM101A operational amplifier,¹ an order of magnitude increase in bandwidth results. A simple feedforward network has also been developed for use with the LM108 micropower amplifier to give a factor of five improvement in speed. It uses no active components and does not degrade the excellent dc characteristics of the LM108.

Figure 1 shows a schematic of an LM108 using the new compensation. The signal from the inverting input is fed forward around the input stage by a 500 pF capacitor, C₁. At high frequencies it provides a phase lead.



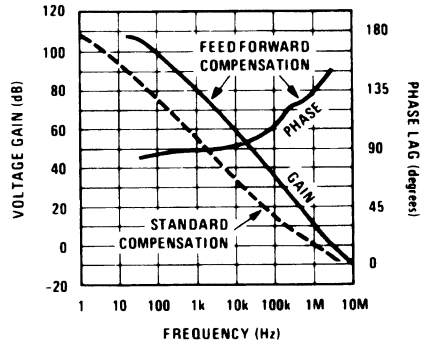
TL/H/7328-1

FIGURE 1. LM108 with Feedforward Compensation

Overall phase shift is reduced and less compensation is needed to keep the amplifier stable. The C₂-R₁ network provides lag compensation, insuring that the open loop gain is below unity before 180° phase shift occurs. The open loop gain and phase as a function of frequency is compared with standard compensation in Figure 2.

The slew rate is increased from 0.3V/μs to about 1.3V/μs and the 1 kHz gain is increased from 500 to 10,000. Small signal bandwidth is extended to 3 MHz. The bandwidth must be limited to 3 MHz because the phase shift through the lateral PNP transistors used in the second stage becomes excessive at higher frequencies. With the LM101A, 10 MHz bandwidth was possible since the signal was bypassed around the low frequency lateral PNP's. Nonetheless, 3 MHz is very respectable for a micropower amplifier drawing only 300 μA quiescent current.

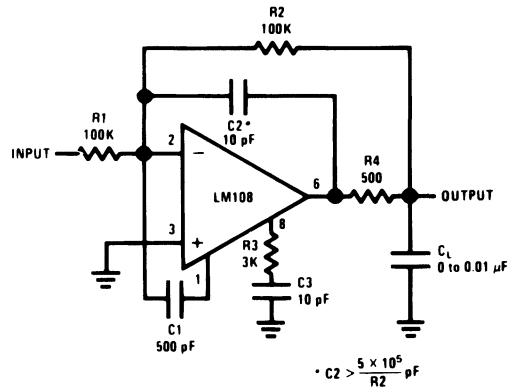
When the LM108 is used with feedforward compensation, it is less tolerant of capacitive loading and stray capacitance. Precautions must be taken to insure stability. If load capaci-



TL/H/7328-2

FIGURE 2. Open Loop Voltage Gain

tance is greater than about 75 to 100 pF, it must be isolated as shown in Figure 3. A small capacitor is always needed to provide a lead across the feedback resistor to compensate for strays at the input. About 3 to 5 pF is the minimum value capacitor. Care must be taken to minimize stray capacitance at Pins 1, 2 and 8 when feedforward compensation is used. Additionally, when the source resistance on the non-inverting input is greater than 10k, it should be bypassed with a 0.1 μF capacitor.



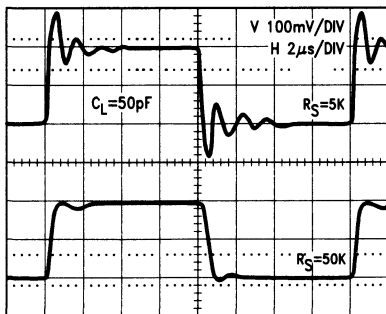
TL/H/7328-3

FIGURE 3. Decoupling Load Capacitance

As with any externally compensated amplifier, increasing the compensation of the LM108 increases the stability at the expense of slew and bandwidth. The circuit shown is for the fastest response. Increasing the size of C₂ to 20 or 30 pF will provide 2 or 3 times greater stability and capacitive

load tolerance. Therefore, the size of the compensation capacitor should be optimized for the bandwidth of the particular application.

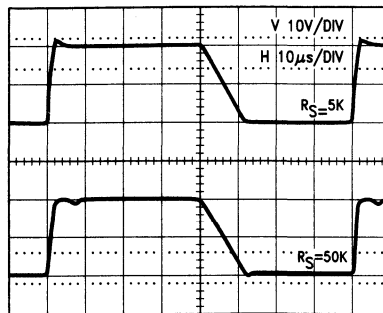
The stability of the LM108 with feedforward compensation is indicated by the small signal transient responses shown in Figure 4. It is quite stable since there is little overshoot and ringing even though the amplifier is loaded with a 50 pF capacitor. Large signal transient response for a 20V square wave is shown in Figure 5. The small positive overshoot is not severe and usually causes no problems.



TL/H/7328-4

FIGURE 4. Small Signal Transient Response of LM108 with Feedforward Compensation

The LM108 is unusually insensitive to power supply bypassing with the new compensation. Even with several feet of wire between the device and power supply, it does not become unstable. However, it is still wise to bypass the sup-



TL/H/7328-5

FIGURE 5. Large Signal Transient Response of LM108 with Feedforward Compensation

plies for drill since noise on the V⁺ line can be injected to the summing junction by the 500 pF feedforward capacitor.

The new feedforward compensation is easy to use and offers a factor of five improvement over standard compensation. Slew rate is increased to 1.3V/µs and power bandwidth extended to 20 kHz. Also, gain error at high frequencies is reduced. This makes the LM108 more useful in precision applications where low dc error as well as low ac error is desired.

REFERENCE

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High Stability Regulators

National Semiconductor
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Monolithic IC's have greatly simplified the design of general purpose power supplies. With an IC regulator and a few external components 0.1% regulation with 1% stability can be obtained. However, if the application requires better performance, it is advisable to use some other design approach.

Precision regulators can be built using an IC op amp as the control amplifier and a discrete zener as a reference, where the performance is determined by the reference. *Figures 1 and 2* show schematics of simple positive and negative regulators. They are capable of providing better than 0.01% regulation for worst case changes of line, load and temperature. Typically, the line rejection is 120 dB to 1 kHz; and the load regulation is better than 10 μ V for a 1A change. Temperature is the worst source of error; however, it is possible to achieve less than a 0.01% change in the output voltage over a -55°C to $+125^{\circ}\text{C}$ range.

The operation of both regulators is straightforward. An internal voltage reference is provided by a high-stability zener diode. The LM108A¹ operational amplifier compares a fraction of the output voltage with reference. In the positive regulator, the output of the op amp controls the ground terminal of an LM109² regulator through source follower, Q₁. Frequency compensation for the regulator is provided by both the R₁ C₂ combination and output capacitor, C₃.

The negative regulator shown in *Figure 2* operates similarly, except that discrete transistors are used for the pass element. A transistor, Q₁, level shifts the output of the LM108 to drive output transistors, Q₃ and Q₄. Current limiting is provided by Q₂. Capacitors C₃ and C₄ frequency compensate the regulator.

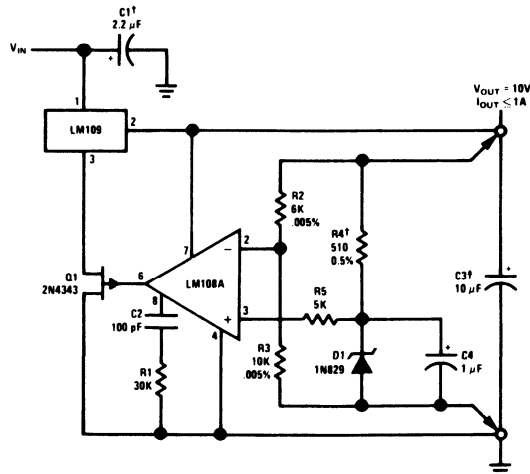
In the positive regulator the use of an LM109 instead of discrete power transistors has several advantages. First, the LM109 contains all the biasing and current limit circuitry needed to supply a 1A load. This simplifies the regulator. Second, and probably most important, the LM109 has ther-

mal overload protection, making the regulator virtually burn-out proof. If the power dissipation becomes excessive or if there is inadequate heat sinking, the LM109 will turn off when the chip temperature reaches 175°C, preventing the device from being destroyed. Since no such device is available for use in the negative regulator, the heat sink should be large enough to keep the junction temperature of the pass transistors at an acceptable level for worst case conditions of maximum ambient temperature, maximum input voltage and shorted output.

Although the regulators are relatively simple, some precautions must be taken to eliminate possible problems. A solid tantalum output capacitor must be used. Unlike electrolytics, solid tantalum capacitors have low internal impedance at high frequencies. Low impedance is needed both for frequency compensation and to eliminate possible minor loop oscillations. The power transistor recommended for the negative regulator is a single-diffused wide-base device. This transistor type has fewer oscillation problems than double diffused transistors. Also, it seems less prone to failure under overload conditions.

Some unusual problems are encountered in the construction of a high stability regulator. Component choice is most important since the resistors, amplifier and zener can contribute to temperature drift. Also, good circuit layout is needed to eliminate the effect of lead drops, pickup, and thermal gradients.

The resistors must be low-temperature-coefficient wire-wound or precision metal film. Ordinary 1% carbon film, tin oxide or metal film units are not suitable since they may drift as much as 0.5% over temperature. The resistor accuracy need not be 0.005% as shown in the schematic; however, they should track better than 1 ppm/°C. Additionally, wire-wound resistors usually have lower thermoelectric effects than film types. The resistor driving the zener is not quite



[†]Determines zener current.
May be adjusted to
minimize thermal drift.

[‡]Solid tantalum

FIGURE 1. High Stability Positive Regulator

TL/H/8465-1

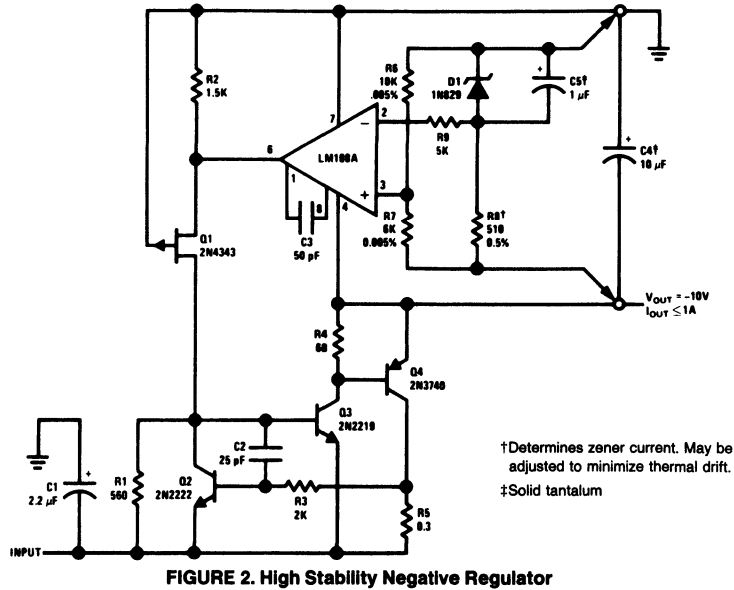


FIGURE 2. High Stability Negative Regulator

as critical; but it should change less than 0.2% over temperature.

The excellent dc characteristics of the LM108A make it a good choice as the control amplifier. The offset voltage drift of less than $5 \mu\text{V}/^\circ\text{C}$ contributes little error to the regulator output. Low input current allows standard cells to be used for the voltage reference instead of a reference diode. Also the LM108 is easily frequency compensated for regulator applications.

Of course, the most important item is the reference. The IN829 diode is representative of the better zeners available. However, it still has a temperature coefficient of $0.0005\%/^\circ\text{C}$ or a maximum drift of 0.05% over a -55°C to $+125^\circ\text{C}$ temperature range. The drift of the zener is usually linear with temperature and may be varied by changing the operating current from its nominal value of 7.5 mA. The temperature coefficient changes by about $50 \mu\text{V}/^\circ\text{C}$ for a 15% change in operating current. Therefore, by adjusting the ze-

ner current, the temperature drift of the regulator may be minimized.

Good construction techniques are important. It is necessary to use remote sensing at the load, as is shown on the schematics. Even an inch of wire will degrade the load regulation. The voltage setting resistors, zener, and the amplifier should also be shielded. Board leakages or stray capacitance can easily introduce $100 \mu\text{V}$ of ripple or dc error into the regulator. Generally, short wire length and single-point grounding are helpful in obtaining proper operation.

REFERENCES

1. R.J. Widlar, "IC Op Amp Beats FETs on Input Current," *National Semiconductor AN-29*, December, 1969.
2. R.J. Widlar, "New Developments in IC Voltage Regulators," in *1970 International Solid-State Circuits Conference Digest of Technical Papers*, Vol. XIII, pp. 158-159.

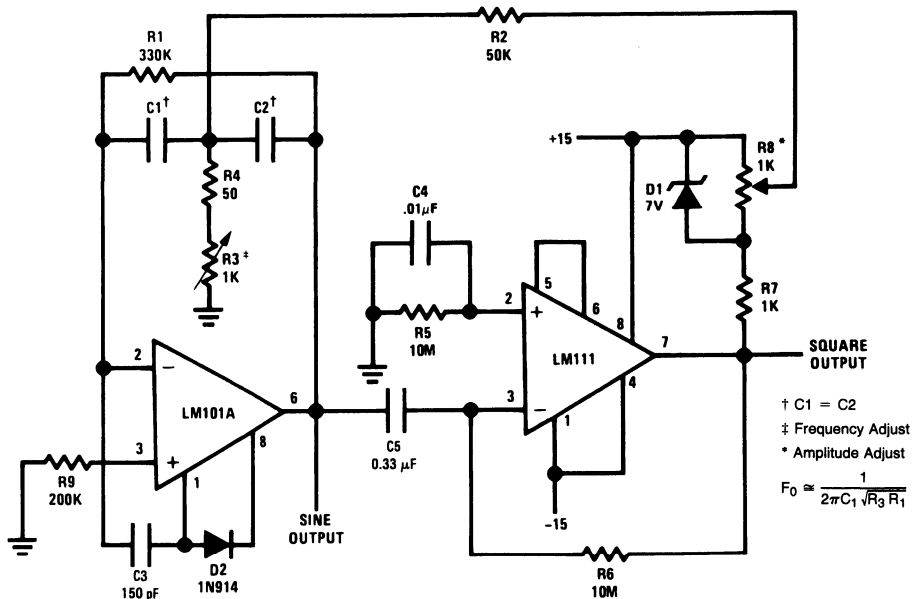
Easily Tuned Sine Wave Oscillators

National Semiconductor
Linear Brief 16



One approach to generating sine waves is to filter a square wave. This leaves only the sine wave fundamental as the output. Since a square wave is easily amplitude stabilized by clipping, the sine wave output is also amplitude stabilized. A clipping oscillator eliminates the problems encountered with agc stabilized oscillators such as those using Wein bridges. Additionally, since there is no slow agc loop, the oscillator starts quickly and reaches final amplitude within a few cycles.

If a lower distortion oscillator is needed, the circuit in *Figure 2* can be used. Instead of driving the tuned circuit with a square wave, a symmetrically clipped sine wave is used. The clipped sine wave, of course, has less distortion than a square wave and yields a low distortion output when filtered. This circuit is not as tolerant of component values as the one shown in *Figure 1*. To insure oscillation, it is necessary that sufficient signal is applied to the zeners for clipping to occur. Clipping about 20% of the sine wave is usually a good value. The level of clipping must be high enough to



TL/H/8466-1

FIGURE 1. Easily Tuned Sine Wave Oscillator

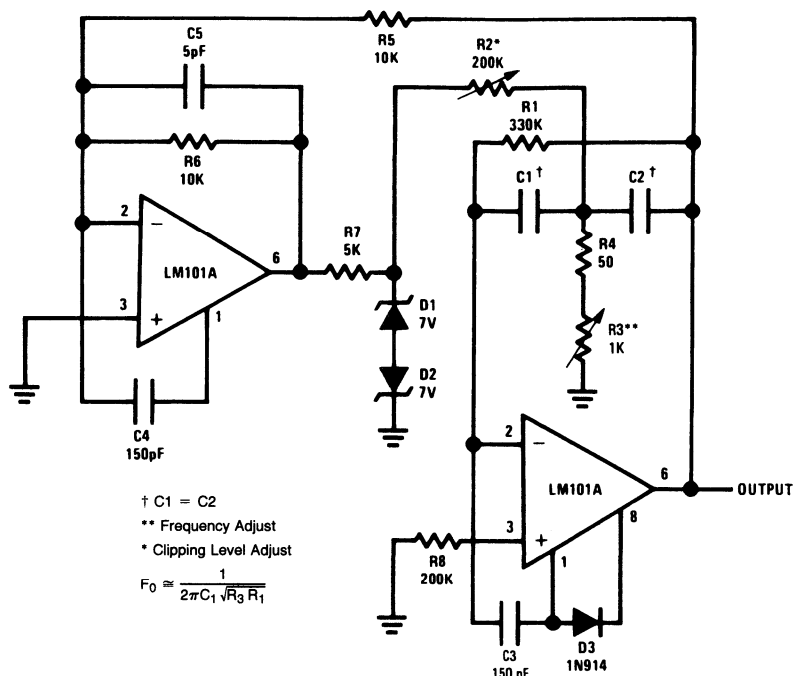
The circuit in *Figure 1* will provide both a sine and square wave output for frequencies from below 20 Hz to above 20 kHz. The frequency of oscillation is easily tuned by varying a single resistor. This is a considerable advantage over Wein bridge circuits where two elements must be tuned simultaneously to change frequency. Also, the output amplitude is relatively stable when the frequency is changed.

An operational amplifier is used as a tuned circuit, driven by square wave from a voltage comparator. Frequency is controlled by R_1 , R_2 , C_1 , C_2 , and R_3 , with R_3 used for tuning. Tuning the filter does not affect its gain or bandwidth so the output amplitude does not change with frequency. A comparator is fed with the sine wave output to obtain a square wave. The square wave is then fed back to the input of the tuned circuit to cause oscillation. Zener diode, D_1 , stabilizes the amplitude of the square wave fed back to the filter input. Starting is insured by R_6 and C_5 which provide dc negative feedback around the comparator. This keeps the comparator in the active region.

insure oscillation over the entire tuning range. If the clipping is too small, it is possible for the circuit to cease oscillation due to tuning, component aging, or temperature changes. Higher clipping levels increase distortion. As with the circuit in *Figure 1*, this circuit is self-starting.

Table 1 shows the component values for the various frequency ranges. Distortion from the circuit in *Figure 1* ranges between 0.75% and 2% depending on the setting of R_3 . Although greater tuning range can be accomplished by increasing the size of R_3 beyond 1 k Ω , distortion becomes excessive. Decreasing R_3 lower than 50 Ω can make the filter oscillate by itself. The circuit in *Figure 2* varies between 0.2% and 0.4% distortion for 20% clipping.

About 20 kHz is the highest usable frequency for these oscillators. At higher frequencies the tuned circuit is incapable of providing the high Q bandpass characteristic needed to filter the input into a clean sine wave. The low frequency end of oscillation is not limited except by capacitor size.



TL/H/8466-2

FIGURE 2. Low Distortion Sine Wave Oscillator

TABLE I

C ₁ , C ₂	Min Frequency	Max Frequency
0.47 μF	18 Hz	80 Hz
0.1 μF	80 Hz	380 Hz
.022 μF	380 Hz	1.7 kHz
.0047 μF	1.7 kHz	8 kHz
.002 μF	4.4 kHz	20 kHz

In both oscillators, feedforward compensation³ is used on the LM101A amplifiers to increase their bandwidth. Feedforward increases the bandwidth to over 10 MHz and the slew rate to better than 10 V/μs. With standard compensation the maximum output frequency would be limited to about 6 kHz.

Although these oscillators are not particularly tricky, good construction techniques are important. Since the amplifiers and the comparators are both wide band devices, proper power supply bypassing is in order. Both the positive and negative supplies should be bypassed with a 0.1 μF disc ceramic capacitor. The fast transition at the output of the comparator can be coupled to the sine wave output by stray

capacitance, causing spikes on the output. Therefore the output of the comparator with the associated circuitry should be shielded from the inputs of the op amp.

Component choice is also important. Good quality resistors and capacitors must be used to insure temperature stability. Capacitor should be mylar, polycarbonate, or polystyrene — electrolytics will not work. One percent resistors are usually adequate.

The circuits shown provide an easy method of generating a sine wave. The frequency of oscillation can be varied over greater than a 4 to 1 range by changing a single resistor. The ease of tuning as well as the elimination of critical a/c loops make these oscillators well suited for high volume production since no component selection is necessary.

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2. R.J. Widlar, "Precision IC Comparator Runs from 5V Logic Supply," *National Semiconductor AN-41*, October, 1970.
3. Robert C. Dobkin, "Feedforward Compensation Speeds Op Amp," *National Semiconductor LB-2*, March, 1969.

LM118 Op Amp Slews 70 V/ μ sec

National Semiconductor
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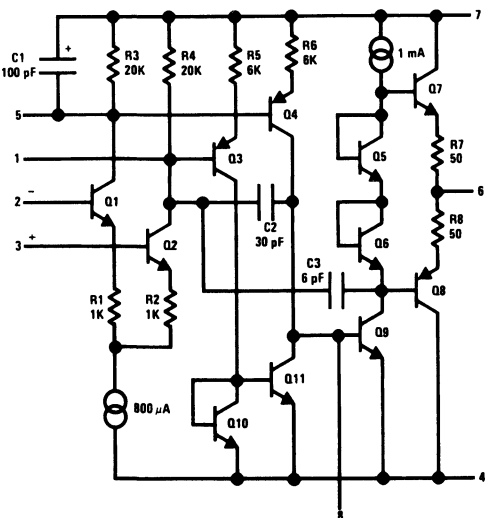


One of the greatest limitations of today's monolithic op amps is speed. With unity gain frequency compensation, general purpose op amps have 1 MHz bandwidth and 0.3 V/ μ s slew rate. Optimized compensation as well as feedforward compensation can improve op amp speed for some applications. Specialized devices such as fast, unity-gain buffers are available which provide partial solutions. This paper will describe a new high speed monolithic amplifier that offers an order of magnitude increase in speed with no loss in flexibility over general purpose devices.

The LM118 is constructed by the standard six mask monolithic process and features 15 MHz bandwidth and 70 V/ μ s slew rate. It operates over a ± 5 to ± 18 V supply range with little change in speed. Additionally, the device has internal unity-gain frequency compensation and needs no external components for operation. However, unlike other internally compensated amplifiers, external feedforward compensation may be added to approximately double the bandwidth and slew rate.

DESIGN CONCEPTS

In general purpose amplifiers the unity-gain bandwidth is limited by the lateral PNP transistors used for level shifting. The response above 2 MHz is so poor that they cannot be used in a feedback amplifier. If the PNP transistors are used for level shifting only at DC or low frequencies and the signal is fed forward around the PNP transistors at high frequencies, wide bandwidth can be obtained without the excessive phase shift of the PNP transistors.



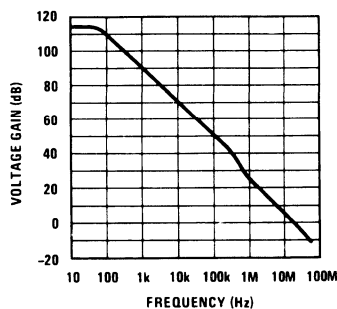
TL/H/6831-1

FIGURE 1. Simplified Circuit of the LM118

Figure 1 shows a simplified schematic of the LM118. Transistors Q₁ and Q₂ are a conventional differential input stage with emitter degeneration and resistive collector loads. Q₃ and Q₄ form the second stage which further amplify the signal and level shift the signal towards V⁻. The collectors of Q₃ and Q₄ drive a current inverter, Q₁₀ and Q₁₁ to convert from differential to single ended. Q₉, which has a cur-

rent source load for high gain, drives a class B output. The collectors of the input stage and the base of Q₉ are available for offset balancing and external compensation.

Frequency compensation is accomplished with three internal capacitors. C₁ rolls off on half the differential input stage so that the high frequency signal path is single-ended. Also, at high frequencies, the signal is fed forward around the lateral PNP transistors by a 30 pF capacitor, C₂. This eliminates the excessive phase shift. Overall frequency response is then set by capacitor, C₃, which rolls off the amplifier at 6 dB/octave. As previously mentioned feedforward compensation for inverting applications can be applied to the base of Q₉. Figure 2 shows the open loop frequency response of an LM118. Table I gives typical specifications for the new amplifier.



TL/H/6831-2

FIGURE 2. Open Loop Voltage Gain as a Function of Frequency for LM118

TABLE I. Typical Specifications for the LM118

Input Offset Voltage	2 mV
Input Bias Current	200 nA
Offset Current	20 nA
Voltage Gain	200k
Common Mode Range	± 11.5 V
Output Voltage Swing	± 13 V
Small Signal Bandwidth	15 MHz
Slew Rate	70 V/ μ s

OPERATING CONFIGURATION

Although considerable effort was taken to make the LM118 trouble free, high frequency amplifiers are more prone to oscillations than low frequency devices such as the LM101A. Care must be taken to minimize the stray capacitance at the inverting input and at the output; however the LM118 will drive a 100 pF load. Good power supply bypassing is also in order—0.1 μ F disc ceramic capacitors should be used within a few inches of the amplifier. Additionally, a small capacitor is usually necessary across the feedback resistor to compensate for unavoidable stray capacitance.

Figure 3 shows feedforward compensation of the LM118 for fast inverting applications. The signal is fed from the summing junction to the output stage driver by C₁ and R₄. Re-

sistors R_5 , R_6 and R_7 have two purposes: they increase the internal operating current of the output stage to increase slew rate and they provide offset balancing. The current boost is necessary to drive internal stray capacitance at the higher slew rate. Mismatch of the external resistors can cause large voltage offsets so offset balancing is necessary. For supply voltages other than $\pm 15V$, R_5 and R_6 should be selected to draw about $500 \mu A$ from Pins 1 and 5.

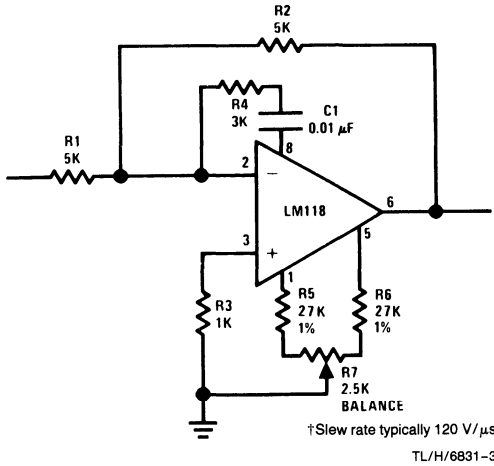


FIGURE 3. Feedforward Compensation for Greater Inverting Slew Rate†

When using feedforward resistor R_4 should be optimized for the application. It is necessary to have about $8 k\Omega$ in the path from the output of the amplifier through the feedback resistor and through feedforward network to Pin 8 of the device. The series resistance is needed to limit the bandwidth and prevent minor loop oscillation.

At high gains, or with high value feedback resistors R_4 can be quite low—but not less than 100Ω . When the LM118 is used as a fast integrator, with a large feedback capacitor or with low values of feedback resistance, R_4 must be increased to $8 k\Omega$ to insure stability over a full $-55^\circ C$ to $+125^\circ C$ temperature range.

One of the more important considerations for a high speed amplifier is settling time. Poor settling time can cancel the advantages of having high slew rate and bandwidth. For example—an amplifier can have severe ringing after a step input. A relatively long time is then needed before the output voltage can be read accurately. Settling time is the time necessary for the output to slew through a defined voltage change and settle to within a defined error of its final output voltage. Figure 4 shows optimized compensation for settling

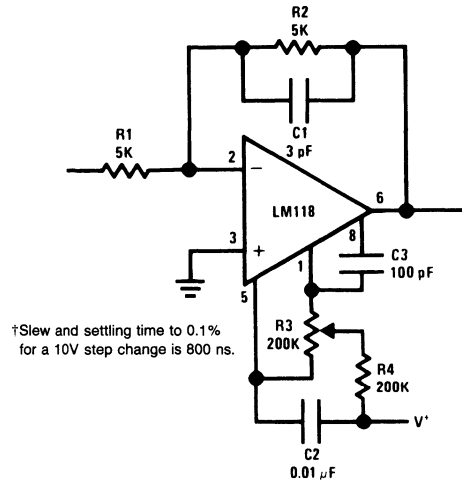


FIGURE 4. Compensation for Minimum Settling† Time

to within 0.1% error. Typically the settling time is 800 ns for a simple inverter circuit as shown. Settling time is, of course, subject to operating conditions external to the IC such as closed loop gain, circuit layout, stray capacitance and source resistance. An optional offset balancing circuit, R_3 and R_4 is included.

The LM118 opens up new fields for IC operational amplifiers. It is more than an order of magnitude faster than general purpose amplifiers while retaining the ease of use features. It is ideally suited for analog to digital converters, active filters, sample and hold circuits and wide band amplification. Further, the LM118 has the same pin configuration as the LM101A or LM741 and is interchangeable with these devices when speed is of prime concern.

+ 5 to - 15 Volts DC Converter

National Semiconductor
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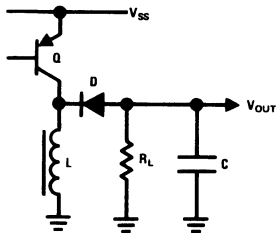
INTRODUCTION

It is frequently necessary to convert a DC voltage to another higher or lower DC-voltage while maximizing efficiency. Conventional switching regulators are capable of converting from a high input DC voltage to a lower output voltage and satisfying the efficiency criteria. The problem is a little more troublesome if a higher output voltage than the input voltage is desired. Particularly, generating DC voltage with opposite polarity to the input voltage usually involves a complicated design.

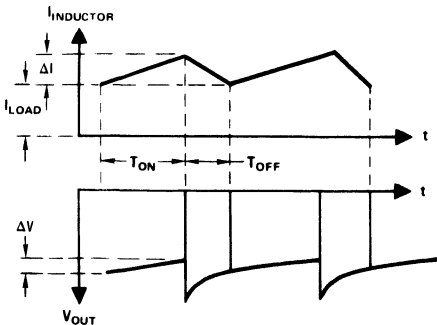
This brief demonstrates the use of the switching regulator idea for a +5 volts to -15 volts converter. The converter has an application as a power supply for MOS memories in a logic system where only +5 volts is available. However, the principle used can be applied for almost any input output combination.

OPERATION

The method by which the regulator generates the opposite polarity is explained in *Figure 1*. The transistor Q is turned ON and OFF with a given duty cycle. If the base drive is sufficient the voltage across the inductor is equal to the



TL/H/8467-1



TL/H/8467-2

FIGURE 1. Switching Circuit for Voltage Conversion
supply voltage minus V_{SAT} . The current change in the inductor is given by:

$$\Delta I = \frac{V_{SS} - V_{SAT}}{L} \times T_{ON} \approx \frac{V_{SS}}{L} T_{ON} \quad (1)$$

Turning OFF the transistor the inductor current has a path through the catch diode and this in turn builds up a negative voltage across R_L .

The figure also shows the current and voltage levels versus time. A capacitor in parallel to the resistor will prevent the voltage from dropping to zero during the transistor ON time. Assuming a large capacitor, we can also write the current change as:

$$\Delta I = \frac{V_{OUT} - V_D}{L} \times T_{OFF} \approx \frac{V_{OUT}}{L} \times T_{OFF} \quad (2)$$

In order to get a general idea of the operation for certain input output conditions, we will develop a set of equations. During the transistor ON time, energy is loaded into the inductor. In the same time interval, the capacitor is drained due to the load resistor R_L .

Drop in capacitor voltage:

$$\Delta V = \frac{I_{LOAD} \times T_{ON}}{C} \quad (3)$$

During the T_{OFF} time the stored energy in the inductor is transferred to the load and capacitor. A rough estimate of T_{OFF} can be expressed as:

$$T_{OFF} = \frac{V_{SS}}{V_{OUT}} \times T_{ON} \quad (4)$$

The capacitor voltage will be restored with an average current given by:

$$I_C = \frac{\Delta V \times C}{T_{OFF}} = \frac{I_{LOAD} \times V_{OUT}}{V_{SS}} \quad (5)$$

The total inductor current during the OFF time can be written as:

$$I_{INDUCTOR} = I_{LOAD} + I_C \quad (6)$$

Inspecting *Figure 1*. We find:

$$I_C = \frac{\Delta I}{2} = \frac{V_{SS} \times T_{ON}}{2 \times L} \quad (7)$$

which yields:

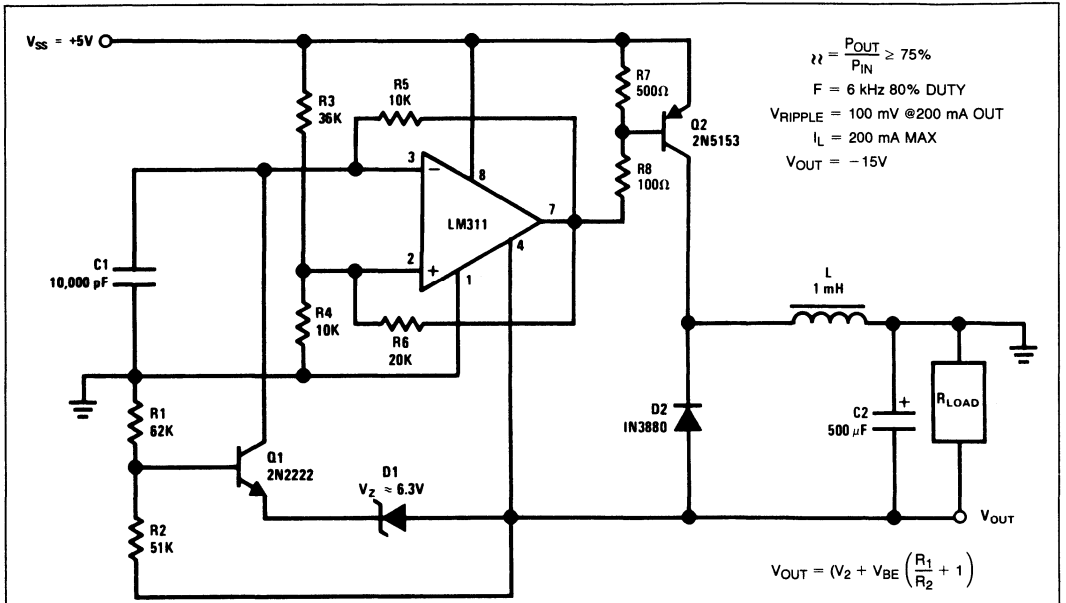
$$T_{ON} = \frac{2 \times L \times I_{LOAD} \times V_{OUT}}{V_{SS}^2} \quad (8)$$

Taking into account that the efficiency is in the order of 75% the final expression is:

$$T_{ON} = \frac{1.5 \times L \times I_{LOAD} \times V_{OUT}}{V_{SS}^2} \quad (9)$$

The above equations will be applied to the regulator shown at *Figure 2*. The regulator must deliver -15 volts at 200 mA from a +5 volt supply. Using a 1 mH inductor the T_{ON} time for Q_2 is 0.18 ms from equation 9. T_{OFF} is 60 μ s from equation 4 and the oscillator frequency to:

$$F = \frac{1}{T_{ON} + T_{OFF}} \approx 4 \text{ kHz}$$



TL/H/8467-3

FIGURE 2. Switching Regulator for Voltage Conversion

The LM311 performs like a free running multivibrator with high duty cycle. The IC is designed to operate from a standard single 5 volt supply and has a high output current capability for driving the switching transistor Q₂. The duty cycle is given by the voltage divider R₃ and R₄ and the frequency of C₁ in conjunction with R₅.

By setting the duty cycle higher than first calculated, the output voltage will tend to increase above the desired output voltage of 15 volts. However, an extra loop performed by Q₁ and the zener diode in conjunction with the resistor network will modify the oscillator duty cycle until the desired output level is obtained.

The output voltage is given by:

$$V_{OUT} = \left(V_Z + V_{BE} \right) \left(\frac{R_1}{R_2} + 1 \right)$$

Data and results obtained with the design:

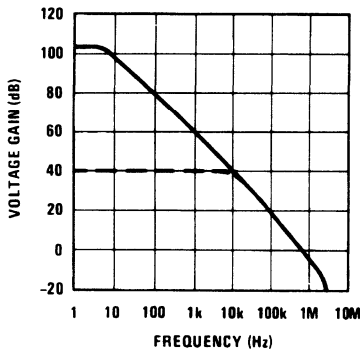
- V_{IN} = 5 volts
- V_{OUT} = -15 volts
- I_{OUT} = max 200 mA
- Efficiency ≈ 75%
- Frequency ≈ 6 kHz 80% duty cycle
- V_{RIPPLE} ≈ 100 mV @ 200 mA load
- Line regulation: V_{IN} = 5V to 10V < 3% V_{OUT}
- I_{LOAD} = 200 mA
- Load regulation: V_{IN} = 5V < 3% V_{OUT}
- I_{LOAD} = 0 - 100 mA

Predicting Op Amp Slew Rate Limited Response

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The following analysis of sine and step voltage responses applies to all single dominant pole op amps such as the LM101A, LM107, LM108A, LM112, LM118 and the LM741. Each of these op amps has an open loop response curve with a shape similar to the one shown in *Figure 1*. The distinguishing feature of this curve is the single low frequency turnover from a flat response to a uniform -20 dB per decade of frequency (-6 dB/octave) drop in gain, at least until the curve passes through the 0 dB line. Closing the loop to 40 dB ($X100$) as shown with a dotted line on *Figure 1* does not change the shape of the curve, but it does move the turnover to a higher frequency. These open loop and closed loop response curves determine the gain applied to small signal inputs. The logical question then arises as to when a signal can no longer be treated as a small signal and the amplifier response begins to deviate from this curve.



TL/H/8726-1

FIGURE 1. Open and Closed Loop Frequency Response

The answer lies in the slew rate limit of the op amp. The slew rate limit is the maximum rate of change of the amplifier's output voltage and is due to the fact that the compensation capacitor inside the amplifier only has finite currents¹ available for charging and discharging. A sinusoidal output signal will cease being a small signal when its maximum rate of change equals the slew rate limit S_r of the amplifier. The maximum rate of change for a sine wave occurs at the zero crossing and may be derived as follows:

$$v_o = V_p \sin 2\pi ft \quad (1)$$

$$\frac{dv_o}{dt} = 2\pi f V_p \cos 2\pi ft \quad (2)$$

$$\left. \frac{dv_o}{dt} \right|_{t=0} = 2\pi f V_p \quad (3)$$

$$S_r = 2\pi f_{\max} V_p \quad (4)$$

where: v_o = output voltage

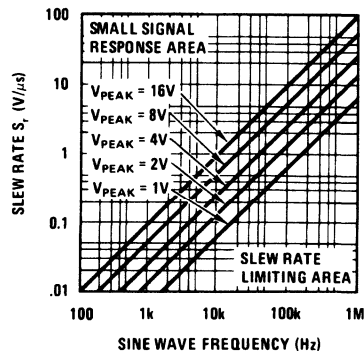
V_p = peak output voltage

S_r = maximum $\frac{dv_o}{dt}$

The maximum sine wave frequency an amplifier with a given slew rate will sustain without causing the output to take on a triangular shape is therefore a function of the peak amplitude of the output and is expressed as:

$$f_{\max} = \frac{S_r}{2\pi V_p} \quad (5)$$

Equation 5 demonstrates that the borderline between small signal response and slew rate limited response is not just a function of the peak output signal but that by trading off either frequency or peak amplitude one can continue to have a distortion free output. *Figure 2* shows a quick reference graphical presentation of equation 5 with the area above any V_{PEAK} line representing an undistorted small signal response and the area below a given V_{PEAK} line representing a distorted sine wave response due to slew rate limiting.



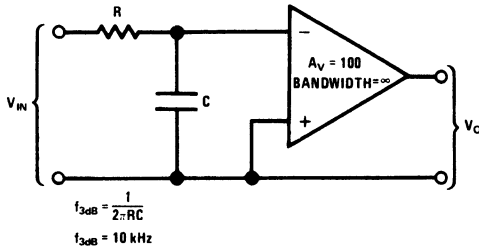
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FIGURE 2. Sine Wave Response

As a matter of convenience, amplifier manufacturers often give a "full-power bandwidth" or "large signal response" on their specification sheets.

This frequency can be derived by inserting the amplifier slew rate and peak rated output voltage into equation 5. The bandwidth from DC to the resulting f_{max} is the full-power bandwidth or "large signal response" of the amplifier. For example the full-power bandwidth of the LM741 with a $0.5V \mu s$ S_r is approximately 6 kHz while the full-power bandwidth of the LM118 with an S_r of $70 V/\mu s$ is approximately 900 kHz.

The step voltage response at the output of an op amp can also be divided into a small signal response and a slew rate limited response. The signal turnover and uniform -20 dB/decade slope shown in the small signal frequency response curve of Figure 1 are also characteristic of a low pass filter and one can in fact model an op amp as a low pass RC filter followed by a very wideband amplifier. Figure 3 shows a model of a X100 circuit with a 3 dB down rolloff frequency of



TL/H/8726-3

FIGURE 3. Small Signal Op Amp Model

10 kHz. From basic filter theory² the 10% to 90% rise time of single pole low pass filter is:

$$t_r = \frac{0.35}{f_{3dB}} \quad (6)$$

which for this example would be $35 \mu s$. Again this small signal or low pass filter response ceases when the required rate of change of the output voltage exceeds the slew rate limit S_r of the amplifier. Mathematically stated:

$$\frac{V_{STEP}}{t_r} \geq S_r \quad (7)$$

This means that as soon as the amplitude of the output step voltage divided by the rise time of the circuit exceeds the S_r of the amplifier, the amplifier will go into slew rate limiting.

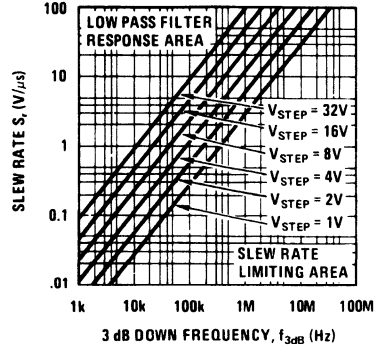
The output will then be a ramp function with a slope of S_r and a rise time equal to:

$$t'_r = \frac{V_{STEP}}{S_r} \quad (8)$$

Substituting equation 6 into equation 7 gives the critical value of V_{STEP} directly in terms of f_{3dB} :

$$\frac{V_{STEP} f_{3dB}}{0.35} \geq S_r \quad (9)$$

which can be graphed as shown in Figure 4. Any point in the area above a V_{STEP} line represents an undistorted low pass filter type response and any point in the area below a given V_{STEP} line represents a slew rate limited response.



TL/H/8726-4

FIGURE 4. Step Voltage Response

The above equations and graphs should allow one to avoid the pitfalls of slew rate limiting and also provide a means of using engineering tradeoffs to extend the response of the single dominant pole type of amplifier.

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2. Millman, J. and Hawkias, C. C.: "Electronic Devices and Circuits", pp. 465-466, McGraw-Hill Book Company, New York, 1967.

A Fully Differential Input Voltage Amplifier

National Semiconductor
Linear Brief 20



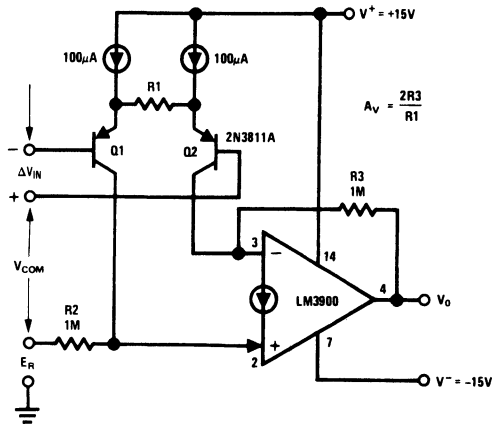
INTRODUCTION

The instrumentation amplifier is useful for amplifying small differential signals which may be riding on high common mode voltage levels. These amplifiers are particularly useful in amplifying signals in the milli-volt range which are supplied from a high impedance source ($> 2 \text{ k}\Omega$).

This brief will demonstrate how a low cost, high performance instrumentation amplifier can be built using the newly introduced LM3900 quad amplifier. It is also indicated how a compact transducer bridge amplifier system can be developed to take advantage of the versatility of the LM3900.

BASIC AMPLIFIER OPERATION

Figure 1 shows the basic operation of the amplifier. The bias of the LM3900 is set by the resistors R_2 and R_3 (neglecting for now, the transistors Q_1 and Q_2). Current which enters the non-inverting input of the LM3900 will be "mirrored" about V^- and then will be drawn into the inverting input terminal. This causes the current to flow through the feedback resistor, R_3 , which establishes the output voltage level. If $R_2 = R_3$ and further, if R_2 is connected to ground (0V), then the output voltage biasing level will also be exactly zero volts. It should be noticed that an *OUTPUT OFFSET CONTROL* can be implemented by supplying a reference voltage, E_R , between R_2 and ground.



TL/H/8468-1

FIGURE 1. Basic Instrumentation Amplifier

Adding transistors Q_1 and Q_2 , as shown in Figure 1 will not disturb this biasing if the two collector currents of the transistors are well matched for a 0V differential input signal. The current sources which bias Q_1 and Q_2 , are chosen to be $100 \mu\text{A}$ each to guarantee high β and low offset voltage in Q_1 and Q_2 .

The gain of the amplifier is calculated as follows:

Any differential input voltage, ΔV_{IN} , appears across R_1 , and produces a current change ΔI , which is given by:

$$\Delta I = \frac{\Delta V_{IN}}{R_1} \quad (1)$$

This current change will show up in the collectors of Q_1 and Q_2 with opposite polarity. The input mirror of the LM3900 returns ΔI_{Q1} to the inverting input terminal where it is added (with sign) to ΔI_{Q2} yielding a total current change of $2\Delta I$. This current flows through the feedback resistor, R_3 , which causes an output voltage change, ΔV_O , which is given by:

$$\Delta V_O = 2\Delta I \times R_3 = 2 \times \frac{\Delta V_{IN}}{R_1} \times R_3 \quad (2)$$

to yield a gain,

$$A_V = 2 \frac{R_3}{R_1} \quad (3)$$

At this point it is convenient to evaluate the result obtained. The gain can be established by one resistor (R_1) according to equation (3). Conventional instrumentation amplifiers usually have a gain given by:

$$A_V = 1 + \frac{\text{Constant}}{R} \quad (4)$$

This means that the minimum gain of unity is obtained if R is left out ($R = \infty$). Note that this is different from the result indicated in equation (3) where unity gain is obtained for

$$R_1 = 2R_3 \quad (5)$$

and minimum gain (or maximum attenuation) is obtained if R_1 is left out ($R_1 = \infty$). This suggests that the amplifier can be turned OFF without disturbing the output voltage dc bias.

The two current sources for Q_1 and Q_2 are implemented with a dual transistor (Q_3 and Q_4) in conjunction with an additional amplifier of the LM3900 as shown in Figure 2. The operation can be easily understood if R_4 and R_5 are incorporated within the amplifier, which then takes the form of a conventional opamp closed loop regulator which maintains a reference voltage (the drop across R_6) at the emitter of Q_4 .

PERFORMANCE

The performance of the complete instrumentation amplifier of Figure 2 is outlined below (Table I and Figure 3).

TABLE I. Typical Performance Characteristics

GAIN

Range of gain -34 dB ($R_1 = \infty$) to 72 dB ($R_1 = 0$)

Gain is set according to: $A_V = \frac{2R_3}{R_1}$

INPUT

Voltage offset referred to input is adjustable to zero. Pos supply less 2.4V

Common-mode and differential input voltage Neg supply less 300 mV

Common-mode rejection ratio at 10 Hz 115dB (gain of 1000)

Bias current (either input) 200 nA

OUTPUT

Output offset is adjustable to zero. 12 mV_{rms} (open loop)

Output noise 3 mV_{rms} ($A_{CL} = 66 \text{ dB}$)

FREQUENCY RESPONSE

Small signal frequency response (-3 dB) 1 MHz (gain of 1000)

3 MHz (gain of 1)

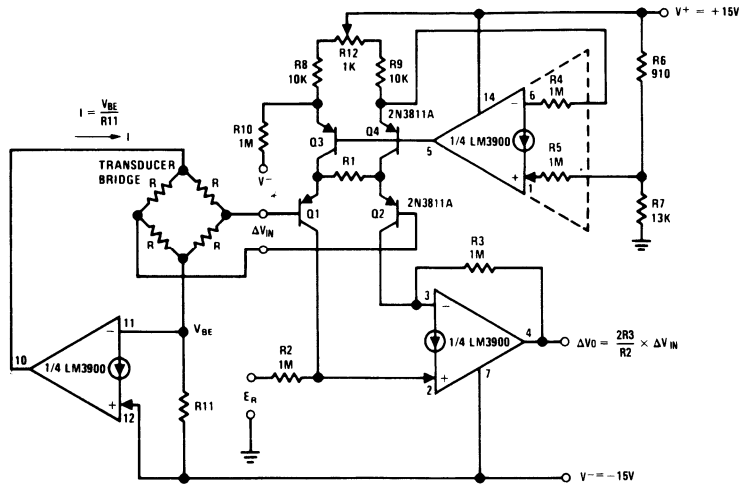


FIGURE 2. Bridge Amplifier

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Since quantitative discussion of the sources of offset voltage is beyond the scope of this brief, only the procedure for nulling the amplifier will be included.

Letting R_1 go to zero causes the amplifier to operate in the open-loop mode. The main offset voltage source is now the V_{BE} mismatch of Q_1 and Q_2 . The output can be nulled by the *OUTPUT OFFSET CONTROL* (the reference voltage for R_2) or by adjusting the value of R_2 . With $R_1 = \infty$, the main offset voltage source is the mismatch in the collector currents of Q_3 and Q_4 . This is easily adjusted via R_{12} . These first and second adjustments interact, however, after repeating the procedure a couple of times a good result is obtained.

TRANSDUCER BIAS SOURCE

Having in mind that the LM3900 consists of four independent amplifiers makes it relatively easy to bias a transducer bridge with a constant current source using only one more of the amplifiers and one resistor. The technique is self-explanatory and is also shown in *Figure 2*.

CONCLUSION

A brief review of a new concept for an instrumentation amplifier has been presented. Many applications can be de-

rived from this basic connection which require amplifying the low level differential signals which are obtained from sensors such as strain gages, pressure transducers, and thermocouples. The performance of this instrumentation amplifier is adequate for many system applications. (See National Semiconductor Application Note 72, "The LM3900 — A New Current-Differencing Quad of \pm Input Amplifiers" for further information.)

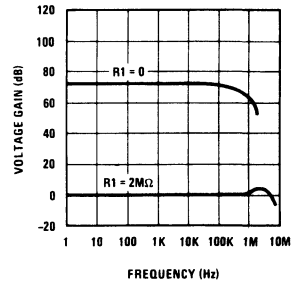


FIGURE 3. Frequency Response

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Instrumentational Amplifiers

National Semiconductor
Linear Brief 21



INTRODUCTION

One of the most useful analog subsystems is the true instrumentation amplifier. It can faithfully amplify low level signals in the presence of high common mode noise. This aspect of its performance makes it especially useful as the input amplifier of a signal processing system. Other features of the instrumentation amplifier are high input impedance, low input current, and good linearity.

It has never been easy to design a high performance instrumentation amplifier; however, the availability of high performance IC's considerably simplifies the problem. IC op amps are available today that can give very low drifts as well as low bias currents; however, most of the circuits have some drawbacks.

The most commonly used instrumentation amplifier designs utilize either 2 or 3 op amps and several precision resistors. These are capable of excellent performance; however, for high performance they require very precisely matched resistors. The common mode rejection of these designs depends on resistor matching and overall gain. Since op amps are now available with exceedingly high CMRR, this is no longer a problem. The CMRR of the instrumentation amplifier is approximately equal to half resistor mismatch plus the gain. For a 1% resistor mismatch the CMRR is limited to 46 dB plus the gain—referred to the input.

Referred to the output, the common mode error is independent of gain and fixed by the resistor mismatch. For 1% match the error is 0.5%, and for 0.1% match the error is 0.05%. These errors are not trivial in high precision systems.

An instrumentation amplifier is shown here that compares favorably with multiple op amp designs, yet does not require precisely matched resistors. Further, the design allows a single resistor to adjust the gain. In comparing this instrumentation amp to multiple op amp types there are of course some drawbacks. The gain linearity and accuracy are not as good as the multiple op amp circuits.

The errors appearing in multiple op amp circuits are independent of the output signal level. For example, a common mode error at the output of 0.5% of full scale is a 33% error if the desired output signal is only 1.5% of full scale. With the new circuit maximum errors at full scale output and the percentage of output error decreases at lower output levels.

Figure 1 shows a general purpose instrumentation amplifier optimized for wide bandwidth. It can provide gains from under 1 to over 1000 with a single resistor adjustment. Gain linearity is worst for unity-gain at 0.4%, and gain stability is better than 1.5% from -55°C to $+125^{\circ}\text{C}$. Typically over a 0°C to $+70^{\circ}\text{C}$ range gain stability is 0.2%. Common mode rejection ratio is about 100 dB—*independent of gain*.

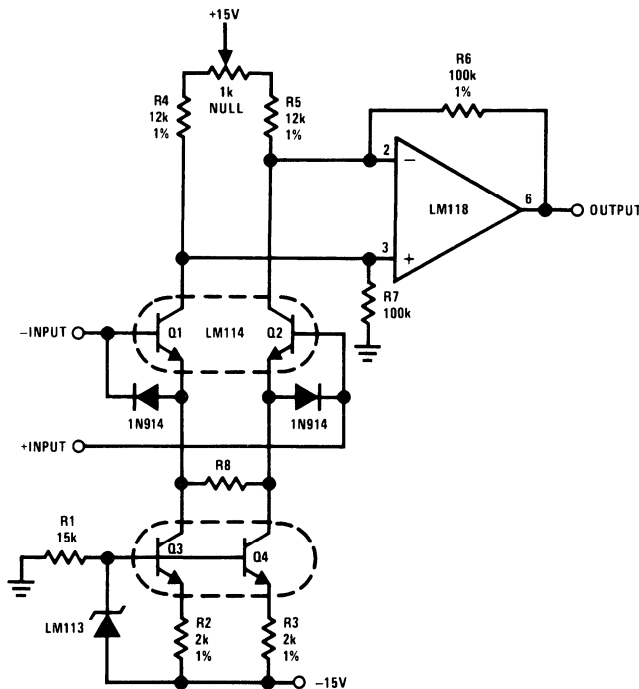


FIGURE 1. Instrumentation Amplifier

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Transistor pair, Q1 and Q2, are operated open-loop as the input stage to give a floating, fully differential input. Current sources, Q3 and Q4, set the operating current of the input pair. To obtain good linearity the output current of Q3 and Q4 are set at about twice the current in R8 at full differential voltage. The temperature sensitivity of the transconductance of Q1 and Q2 is compensated by making their operating current directly proportional to absolute temperature. It has been shown that by biasing the base of transistor current sources at 1.22V, the output current varies as absolute temperature. The LM113 diode provides a constant 1.22V to the current sources. Both the compensated gm of Q1 and Q2 and the large degeneration from R8 give the amplifier stable gain over a wide temperature range.

In operation, transistors Q1 and Q2 convert a differential input voltage to a differential output current at their collectors. This is fed into a standard differential amplifier to obtain a single ended output voltage. Since the diff amp does not see the common mode input voltage, 1% resistors are adequate. Gain is set by the ratio of R8 (plus the r_e of Q1 and Q2) to the sum of R6 and R7.

As mentioned previously this circuit is optimized for wide bandwidth; however, it is easily modified for other applications. If low bias current is needed, all resistors can be increased by a factor of 100 and an LM108 substituted for the LM318. Other possible improvements are cascaded current sources and a modified Darlington input stage.

Low Drift Amplifiers

National Semiconductor
Linear Brief 22



INTRODUCTION

Since the introduction of the monolithic IC amplifier, there has been a continued improvement in DC accuracy. Bias currents have been decreased by five orders of magnitude over the past five years. Low offset voltage drift is also necessary in high-accuracy circuits. This is evidenced by the popularity of low-drift amplifier types as well as requests for selected low-drift op amps. However, little has been written about the problems associated with handling microvolt signals with a minimum of errors.

A very low drift amplifier poses some uncommon application and testing problems. Many sources of error can cause the apparent circuit drift to be much higher than would be predicted. In many cases, the low drift of the op amp is completely swamped by external effects while the amplifier is blamed for the high drift.

Thermocouple effects caused by temperature gradient across dissimilar metals are perhaps the worst offenders. Whenever dissimilar metals are joined, a thermocouple results. The voltage generated by the thermocouple is proportional to the temperature difference between the junction and the measurement end of the metal. This voltage can range between essentially zero and hundreds of microvolts per degree, depending on the metals used. In any system using integrated circuits, a minimum of three metals are found: copper, solder, and kovar (lead material of the IC).

Nominally, most parts of the circuit are at the same temperature. However, a small temperature gradient can exist across even a few inches—and this is a big problem with the low level signals. Only a few degrees gradient can cause hundreds of microvolts of error. Two places where this shows up, generally, are the package-to-printed-circuit-board interface and temperature gradients across resistors. Keeping package leads short and the two input leads close together help greatly.

For example, a very low drift amplifier was constructed and the output monitored over a 1-minute period. During the one minute it appeared to have input referred offset variations of $\pm 5.0 \mu\text{V}$. Shielding the circuit from air currents reduced this to $\pm 0.5 \mu\text{V}$. The $10 \mu\text{V}$ error was due to thermal gradients across the circuit from air currents.

Resistor choice as well as physical placement is important for minimizing thermocouple effects. Carbon, oxide film, and some metal-film resistors can cause large thermocouple errors. Wirewound resistors of evenohm or managanin are best since they only generate about $2.0 \mu\text{V}/^\circ\text{C}$ referenced to copper. Of course, keeping the resistor ends at the same temperature is important. Generally, shielding a low-drift stage electrically and thermally yields good results.

Resistors can cause other errors besides gradient generated voltages. If the gain setting resistors do not track with temperature, a gain error will result. For example, a gain-of-1000 amplifier with a constant 10 mV input will have 10V output. If the resistors mismatch by 0.5% over the operating temperature range, the error at the output is 50 mV. Referred to input, this is a $50 \mu\text{V}$ error. Most precision resistors use different material for different ranges of resistor values. It is not unexpected that a resistor differing by a factor of 1000 does not track perfectly with temperature. For best

results, ensure that the gain fixing resistors are of the same material or have tracking temperature coefficients.

It is appropriate to mention offset balancing as this can have a large effect on drift. Theoretically, the drift of a transistor differential amplifier depends on the offset voltage. For every millivolt of offset voltage the drift is $3.6 \mu\text{V}/^\circ\text{C}$. Therefore, if the offset is nulled, the drift should be zero. When working with IC op amps, this is not the case. Other effects, such as second stage drift and internal resistor TC, make the drift nontheoretical.

Certain types of amplifiers are optimized to have lower drift with offset balancing such as the LM121 and LM725. With this type of device offset, nulling improves the drift, and offset nulling should be used. Other types of devices, such as selected LM741's or LM308's, are selected for the drift without offset nulling connected to the device. The addition of a balancing network changes the internal currents and thus changes the drift—probably for the worse—so any offset balancing should be done at the input.

No matter which null network is applied, highly stable resistors must be used. They should have low TC and track. Wirewound pots are usually a good choice. Finally, when the null network reduces a drift, the balancing of the amplifier as close to zero offset as possible minimizes the drift.

Testing low-drift amplifiers is also difficult. Standard drift testing techniques such as heating the device in an oven and having the leads available through a connector, thermoprobe, or the soldering iron method do not work. Thermal gradients can cause much greater errors than the amplifier drift. Coupling microvolt signal through connectors is especially bad since the temperature difference across the connector can be 50°C or more. The device under test, along with the gain setting resistor, should be isothermal. The circuit in *Figure 1* will yield good results if well constructed.

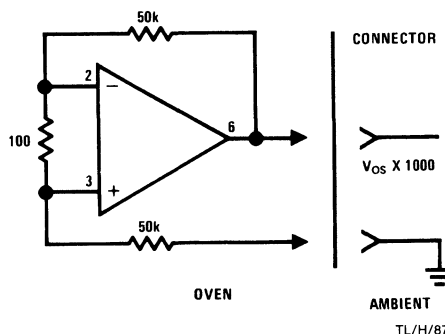


FIGURE 1. Drift Measurement Circuit

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CONCLUSION

Low-drift amplifiers need extreme care to achieve reproducible low drift. Thermal and electrical shielding minimize thermocouple effects. Resistor choice is also important as they can introduce large errors. Careful attention to circuit layout offset balancing circuitry is also necessary.

Precise Tri-Wave Generation



INTRODUCTION

The simple Tri-wave generator has become an often used analog circuit. Tri-wave oscillators are more easily designed, require less circuitry, and are more easily stabilized than sine wave oscillators. Further, the highly linear output of today's Tri-wave generators make them useful in many "sweep" circuits and test equipment.

This article describes a triangle wave generator with an easily controlled peak-to-peak amplitude. The positive and negative peak amplitude is controllable to an accuracy of about $\pm 0.01V$ by a DC input. Also, the output frequency and symmetry are easily adjustable.

CIRCUIT DESCRIPTION

The Tri-wave oscillator consists of an integrator and two comparators—one comparator sets the positive peak and the other the negative peak of the Tri-wave. To understand the operation, assume that the output of the comparator is low ($-5V$). Then $-5.0V$ is applied through $R1$ to the input of the integrator. The LM118 will integrate positive until its output is equal to the positive reference on pin 9 of the LM119. Since the comparator outputs are low, $D1$ is reverse biased and the full output of the integrator is applied to the non-inverting input of comparator A. As the integrator output crosses the positive reference, comparator A switches "plus" and latches "plus" from positive feedback through $D1$ and $R4$. Now the polarity of the current to the integrator has changed and the integrator starts ramping negative. When the output reaches the negative reference voltage, comparator B swings negative. This forces the output of comparator A negative, also, and stops the positive feedback through $D1$ from holding the comparator's outputs positive. Once the positive feedback loop is broken, the outputs of the comparators stay low. With the comparator's outputs low, the integrator ramps positive again.

The frequency of operation is dependent upon $R1$, $C1$ and the reference voltages. Frequency is given by:

$$F = \frac{5.0V}{2R1 C1 (V_{REF+} - V_{REF-})}$$

The maximum frequency of operation is limited by the circuit delay to about 200 kHz. Also, the maximum difference in reference voltages is 5.0V.

APPLICATIONS

Regular or op amp testing is made easier with precise triangle waves. For example, IC voltage regulators are usually specified to operate over a certain input voltage range such as 7.0V to 25V. The Tri-wave generator can be set to deliver a 0.7V to 2.5V output. This output is then amplified by a factor of 10 by an op amp and used to sweep the regulator input over its operating range. With op amps, the generator can be used to sweep common mode voltages, power supply voltages, or even to test output swing. The output of the device can be displayed on an oscilloscope and performance monitored over the entire operating range.

Another application is a voltage controlled oscillator. Since the frequency depends on the input reference voltage, varying the reference varies the frequency. The useful VCO range is about 2 decades. The output is then taken from the comparators as the Tri-wave changes in amplitude.

Many sine wave oscillators use a non-linear network to convert triangle wave to sines. It is usually necessary to set triangle amplitude precisely for minimum distortion. If $R1$ is replaced by a pot, frequency can be varied over at least 10 to 1 range without affecting amplitude.

Symmetry is also easily adjustable. Current can be injected into the inverting input of the LM118 to change ramp time. The easiest way to achieve this is to connect a 50 k Ω resistor from the inverting input of the LM118 to the arm of a 1 k Ω pot. The ends of the pot are connected across the supplies. Current from the resistor either adds or subtracts from the current through $R1$, changing the ramp time.

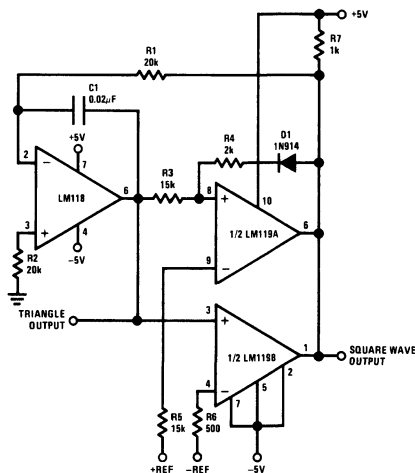


FIGURE 1. Precision Tri-Wave Generator

TL/H/8729-1

Versatile IC Preamplifier Makes Thermocouple Amplifier with Cold Junction Compensation

National Semiconductor
Linear Brief 24



INTRODUCTION

Accurate electronic temperature measurements are not simple. There exists a large array of temperature sensors; each with its own peculiarities. The major sensors are thermistors, resistance sensors, and thermocouples. (Diodes and transistors have been used but they are not normally sold for this purpose.) Thermistors are highly non-linear, making wide range measurements difficult. Resistance sensors are large, require a bridge, and tend to be relatively costly. Thermocouples are small, relatively linear, inexpensive, but require reference junction temperature compensation.

Thermocouples are made when wires of different metals are joined. A voltage is produced proportional to the temperature *difference* between the junction and the output ends of the wire. This voltage is the Seebeck coefficient and is usually specified in volts (or microvolts) per degree. Depending on the material, it can range from nearly zero to volts—for some semiconductors. Commercially available thermocouples produce an output of between $10 \mu\text{V}/^\circ\text{C}$ and $50 \mu\text{V}/^\circ\text{C}$. Since the output voltage of thermocouples is proportional to temperature difference, the ambient temperature or measurement end of the thermocouple must be known. Alternatively, compensation can be applied for temperature changes. This is done either by terminating the thermocouple in a temperature controlled environment or with electrical com-

pensation circuitry. The amplifier shown here provides a direct reading output of $10 \text{ mV}/^\circ\text{C}$ and automatically compensates for reference junction temperature changes. Further, calibration is relatively simple.

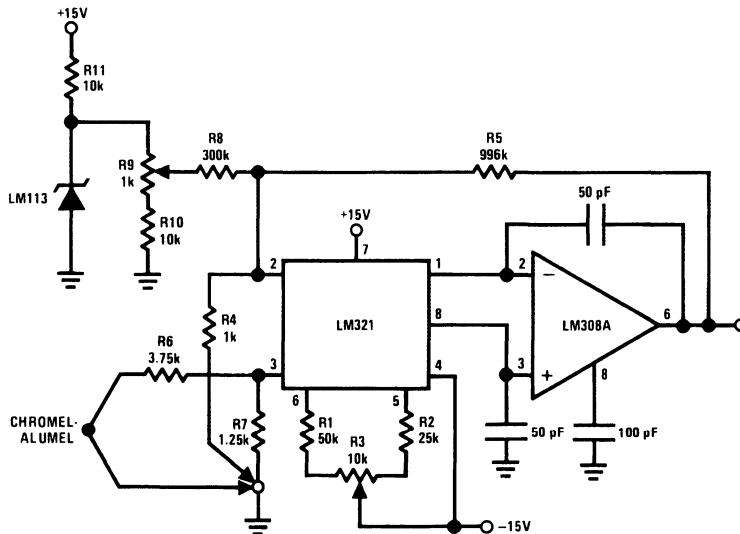
CIRCUIT DESCRIPTION

An LM321 preamp is used in conjunction with an LM308A op amp to form a precision, low-drift, operational amplifier. The LM321 is specifically designed for use with general purpose op amps to obtain drifts of $1 \mu\text{V}/^\circ\text{C}$. When the offset voltage is nulled, the drift is also nulled. There is a theoretical relationship between the offset voltage and drift when the offset is not nulled to zero. The drift of the amplifier is then used to compensate the thermocouple for ambient temperature variations. Drift given by:

$$\frac{dV_{OS}}{dT} = \frac{V_{OS}}{T}$$

where T is in degrees Kelvin.

Resistors R1, R2, and R3 set the operating current of the preamp, and R3 is used to adjust the offset. The offset and drift are amplified by the ratio of the feedback resistors R4 and R5 and appear at the output. R6 and R7 attenuate the thermocouple's output to $10 \mu\text{V}/^\circ\text{C}$ to match the amplifier drift and set the scale factor at $10 \text{ mV}/^\circ\text{C}$. The LM113 provides a temperature stable reference for offsetting the output to read directly in degrees centigrade.



TL/H/8730-1

CALIBRATION

Calibration is independent of thermocouple type; however, circuit values are for chromel alumel. R6 and R7 must be changed for different thermocouples. First, the thermocouple is replaced by a short of copper wire and the LM113 is shorted to ground. Then the offset is adjusted so the output reads the ambient temperature at 10 mV/°k—for 25°C this is 2.98V. The short across the LM113 is removed and R9 is adjusted for the correct output in degrees centigrade. Connect the thermocouple, and it's ready to go.

PERFORMANCE

It should be mentioned that for stable performance, good construction techniques are necessary. Resistors R4, R6, and R7 should be wirewound so they contribute a minimum of error due to thermocouple effects from temperature gra-

dients across the circuit. The entire circuit should be enclosed in a box with the end of the thermocouple terminated in the box near the LM321. This will minimize temperature gradients across the circuit and insure close thermal coupling between the LM321 and the reference end of the thermocouple.

Typically, the LM321 will track temperature changes with less than 0.03°C error per degree change. Self-heating of the LM321 will change its temperature by about 2°C; this is calibrated out initially. Reference and resistor drift can be expected to contribute about 0.02°C/°C. Of course, no compensation is made for nonlinearities of the thermocouple output voltage as a function of temperature. Over a wide measurement range with relatively stable ambient temperature, thermocouple error will be the major inaccuracy.

True rms Detector

National Semiconductor
Linear Brief 25



INTRODUCTION

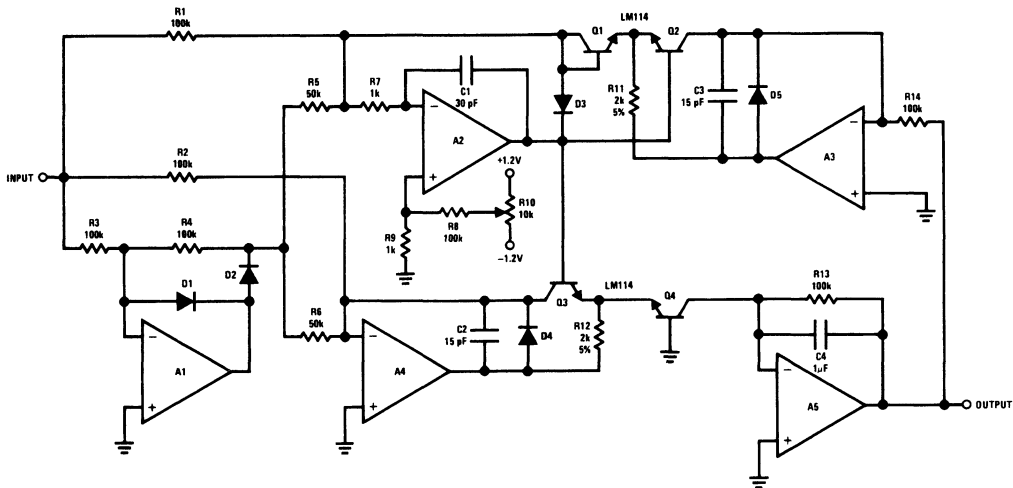
The op amp precision rectifier circuits have greatly eased the problems of AC to DC conversion. It is possible to measure millivolt AC signal with a DC meter with better than 1% accuracy. Inaccuracy due to diode turn-on and nonlinearity is eliminated, and precise rectification of low level signals is obtained.

Once the signal is rectified, it is normally filtered to obtain a smooth DC output. The output is proportional to the average value of the AC input signal, rather than the root mean square. With known input waveforms such as a sine, triangle, or square; this is adequate since there is a known proportionality between rms and average values. However, when the waveform is complex or unknown, a direct readout of the rms value is desirable.

The circuit shown will provide a DC output equal to the rms value of the input. Accuracy is typically 2% for a 20 V_{p-p}

input signal from 50 Hz to 100 kHz, although it's usable to about 500 kHz. The lower frequency is limited by the size of the filter capacitor. Further, since the input is DC coupled, it can provide the true rms equivalent of a DC and AC signal.

Basically, the circuit is a precision absolute value circuit connected to a one-quadrant multiplier/divider. Amplifier A1 is the absolute value amplifier and provides a positive input current to amplifiers A2 and A4 independent of signal polarity. If the input signal is positive, A1's output is clamped at -0.6V, D2 is reverse biased, and no signal flows through R5 and R6. Positive signal current flows through R1 and R2 into the summing junctions of A2 and A4. When the input is negative, an inverted signal appears at the output of A1 (output is taken from D2). This is summed through R5 and R6 with the input signal from R1 and R2. Twice the current flows through R5 and R6 and the net input to A2 and A4 is positive.



Note 1: All operational amplifiers are LM118.

Note 2: All resistors are 1% unless otherwise specified.

Note 3: All diodes are 1N914.

Note 4: Supply voltage $\pm 15V$.

TL/H/8474-1

Amplifiers A2 through A5 with transistors Q1 through Q4 form a log multiplier/divider. Since the currents into the op amps are negligible, all the input currents flow through the logging transistors. Assuming the transistors to be matched, the V_{be} of Q4 is:

$$V_{be}(Q4) = V_{be}(Q1) + V_{be}(Q3) - V_{be}(Q2)$$

The V_{be} 's of these transistors are logarithmically proportional to their collector currents so

$$\log(I_{C4}) = \log(I_{C1}) + \log(I_{C3}) - \log(I_{C2})$$

$$\text{or } I_{C4} = \frac{I_{C1}I_{C3}}{I_{C2}}$$

where I_{C1} , I_{C2} , I_{C3} , and I_{C4} are the collector currents of transistors Q1-Q4.

Since I_{C1} equal I_{C3} and is proportional to the input, the square of the input signal is generated. The square of the input appears as the collector current of Q4. Averaging is done by C4, giving a mean square output. The filtered

output of Q4 is fed back to Q2 to perform continuous division where the divisor is proportional to the output signal for a true root mean square output.

Due to mismatches in transistors, it is necessary to calibrate the circuit. This is accomplished by feeding a small offset into amplifier A2. A 10V DC input signal is applied, and R10 is adjusted for a 10V DC output. The adjustment of R10 changes the gain of the multiplier by adding or subtracting voltage from the log voltages generated by the transistors. Therefore, both the resistor inaccuracies and V_{be} mismatches are corrected.

For best results, transistors Q1 through Q4 should be matched, have high beta, and be at the same temperature. Since dual transistors are common, good results can be obtained if Q1, Q2 and Q3, Q4 are paired. They should be mounted in close proximity or on a common heat sink, if possible. As a final note, it is necessary to bypass all op amps with 0.1 μ F disc capacitors.

Specifying Selected Op Amps and Comparators

National Semiconductor
Linear Brief 26



It is not infrequent that commercially available standard IC components do not fit a particular application as they are specified. Often, however, a standard device selected to tighter limits will work. Thereupon, the IC manufacturer may be requested to supply a specially tested device.

The usual chain of events for a selected part is as follows: A specification is sent to the manufacturer with a request for quote. It is evaluated at the manufacturer for feasibility, yield, and testing requirements. Then price and delivery are quoted to the customer. (Sometimes this route is shortened by calling the manufacturer—but this does not always work.)

Some insight into the IC design and IC testing can help both the manufacturer and IC user with special selection. Proper specification helps the manufacturer test as well as reduce IC costs. Ambiguous or impossible specs will usually result in the return of the specification to the customer for clarification and delay the delivery of the required parts.

The manufacturer is usually familiar with the product and production spread of devices. Further, test equipment is available for measuring parameters specified by the data sheet. In general, tightening selected data sheet parameters causes no problems. Further, no additional test equipment is needed for these tests—only the limits need be changed.

Perhaps one of the largest problems is over-specification. Each tightened specification reduces the number of parts available to the specification. For example, tightening several specifications at once could result in a 1% or 0.1% yield; to supply 100 parts at this yield, between 10,000 and 100,000 parts might have to be tested, and that gets expensive.

Of course, spec limits cannot be tightened to any desired value. This is due to limitations on the IC design. For example, bias current, which depends on transistor H_{FE} , can not be tightened by a factor of 10. This would require beta's 10 times higher than normal. Also, some specifications are not independent, such as op amp bandwidth and slew-rate.

OP AMP AND COMPARATORS

These are the two most popular linear IC components requiring selection. Since many of the same specifications apply to both types of devices, they will be covered together. Table I shows the most common parameters tested on these devices and the relative difficulty of testing on high speed equipment.

Selected offset voltage and drift are very commonly specified parameters. Offset voltage and drift depends on component matching. In general, drift is not usually tested on general purpose devices; although, it may be guaranteed. Offset voltage can be correlated to drift, and the offset limits are set to guarantee the standard drift specification. Of course, very low drift devices must be 100% tested for drift, making them relatively expensive. Drift testing requires

measuring the offset voltage at three or more temperatures; then subtracting and dividing by the temperature change to obtain the drift—a long and tedious measurement.

In some cases tightened offset voltage specifications over the operating temperature range offer the same performance as a drift tested device, but are less expensive. This is because offset voltage measurement can be a go/no-go measurement. For example, $15 \mu\text{V}/^\circ\text{C}$ can be guaranteed over a 100°C range by limiting the maximum offset voltage to $\pm 0.75 \text{ mV}$ or a 1.5 mV band. If the application has an error budget of $\pm "X"$ volts, it may be better to tighten the offset voltage rather than have the manufacturer to drift test. Drift testing a comparator is virtually impossible since they are not designed to operate closed loop.

Other parameters dependent upon matching are: offset current, common mode rejection, and supply rejections. These can be greatly tightened at the expense of yield.

Bias current, supply current, gain, slew rate, and response time are dependent upon both device design and processing. The limits for tighter parameters on these specifications are more restrictive. Table II gives reasonable special selection limits. This is only a guideline and, of course, depends on the device.

Noise testing is in a class by itself. Op amp noise will vary between manufacturers of the same device. Further, noise will vary between different types of devices from the same manufacturer. Since noise on a particular device is mostly process dependent, it will be relatively consistent from a single IC producer.

Noise can be broken into two categories: white noise, and popcorn noise. Both of these noise sources can be either voltage or current noise. It is possible with advanced processing to make IC transistors as good as the best discrete low noise transistors. With good processing only a very small percentage of op amps will have any popcorn noise.

Noise measurements are time consuming and costly. Popcorn noise testing may take as much as 30 seconds per unit which limits production to about 100 devices per hour. This low production rate will increase costs. If not absolutely necessary—do not specify noise.

As a final note, some mention should be made of other special testing. Anything reasonable can be done; however, it should be kept in mind that accurate specification in terms of the IC parameters is necessary. It is unlikely a positive result will come from a specification showing a system schematic, system output, and stating "select devices to produce desired outputs." Although this is an exaggeration, it points out the type of specification to be avoided. Performance specification should apply to the IC not to a circuit using the IC. Many manufacturers have circuits available showing the various electrical tests and the way they are done.

TABLE I. Relative Ease of Parameter Testing

Parameter	Op Amp	Comparator	Cost
Offset Voltage	Easy	Easy	Low
Offset Current	Easy	Easy	Low
Bias Current	Easy	Easy	Low
Supply Current	Easy	Easy	Low
Common Mode/Supply Rejection	Easy	Easy	Low
Gain	Moderate	Moderate	Low
Input Resistance	Guaranteed by Bias Current Measurement	Guaranteed by Bias Current Measurement	Not Tested
Slew Rate	Moderate	Moderate	Relatively Low
Bandwidth/Response Time	Difficult	Difficult	Moderate
Offset Voltage Drift	Very Difficult	Very Difficult	High
Offset Current Drift	Very Difficult	Very Difficult	High

TABLE II. Guideline to Tightened Specifications

Parameters	Limit	Comments
Offset Voltage	0.1 mV	Matching
Offset Current	-50% of Nominal	Matching
Bias Current	-50% of Nominal	Depends on H_{fe}
Supply Current	-25% of Nominal	Depends on Various Process Parameters
Gain	+100% of Nominal	Set by Design
Common Mode/Supply Rejection	+200% of Nominal	Matching
Slew Rate	+30% of Nominal	Set by Design
Bandwidth	+30% of Nominal	Set by Design
Response Time	-30% of Nominal	Set by Design and Processing
Offset Voltage Drift	0.2 $\mu\text{V}/^\circ\text{C}$ to 5 $\mu\text{V}/^\circ\text{C}$	Lower Limit May Not Apply to Many Op Amps
Offset Current Drift	Guarantee by Offset Current Limit	

Micropower Thermometer

National Semiconductor
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The introduction of a monolithic temperature transducer for the -55°C to $+125^{\circ}\text{C}$ temperature range can considerably simplify the problems encountered in temperature measurement. The three most common sensors—thermistors, resistance sensors, and thermocouples—require a reasonable amount of circuitry for use. Thermistors are highly non-linear, resistance sensors and thermistors require a stable excitation voltage, and thermocouples have low output. Further, none of these sensors provide an output directly calibrated in a known temperature scale.

The new monolithic temperature transducer provides an output directly proportional to absolute temperature at $10\text{ mV}/^{\circ}\text{K}$. The chip includes a temperature stable voltage reference and op amp. These allow the output to be offset and scaled to provide any desired temperature scale factor and zero output temperature.

THERMOMETER DESIGN

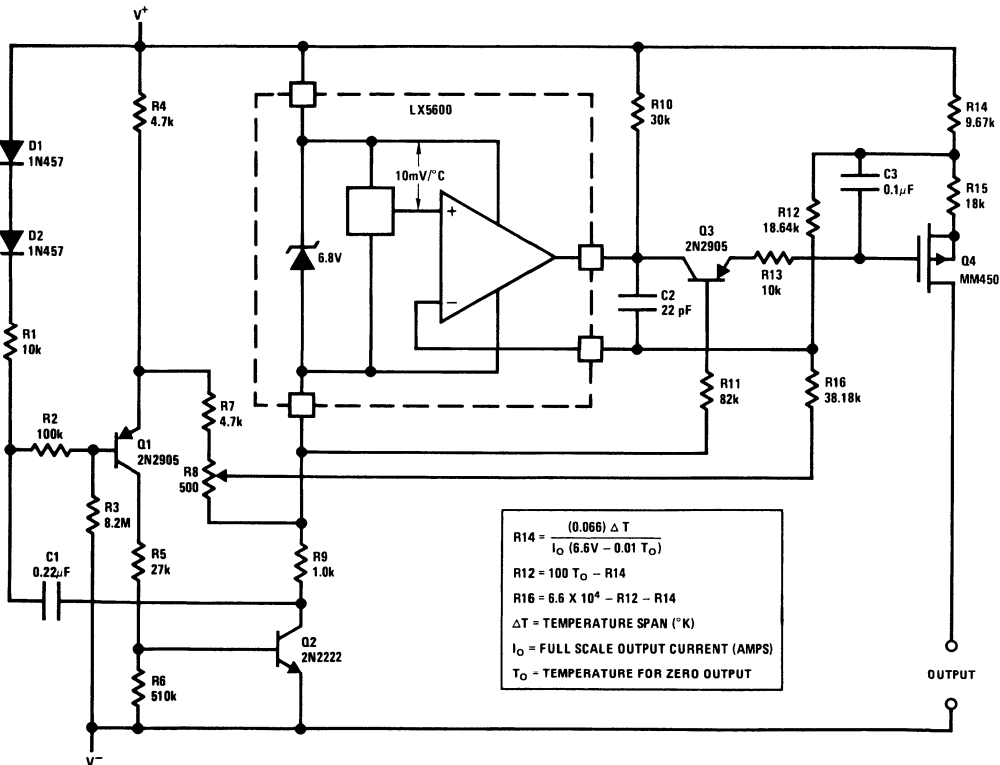
The circuit shown will provide a temperature sensitive output with both zero and scale factor independently select-

able. Since the temperature transducer requires about 1.0 mA for normal operation, the thermometer is pulsed at a low duty cycle to reduce power consumption. A continuous output is obtained between pulses by a sample and hold. Since temperature does not usually change rapidly, the pulsed operation of the thermometer does not detract from its usefulness.

With the components shown, duty cycle is about 0.2% with a one second sample rate. This gives an average current drain of about $25\text{ }\mu\text{A}$ plus the output current. It is designed to operate over a supply voltage of 8.0V to 12V with good results. A small 8.4V mercury battery can give an operational life in excess of one year.

The output of the thermometer is a current proportional to temperature which can be used to drive a meter for a direct readout. Alternatively, a resistor or op amp can be used to obtain a voltage output.

A complementary astable multivibrator, made of Q1 and Q2, drives the LX5600 through R9. The timing is set by several



Micropower Thermometer Circuit Diagram

TL/H/8476-1

components. C1 and R3 control the off-time and C1, R1, R4 and R7 control the on-time. R9 sets the operating current of the transducer to 1.0 mA at the lowest supply voltage.

When the transducer is "on," sample transistor Q3 is also on. The output of the op amp drives the sample capacitor, C3, and MOSFET, Q4. Feedback is obtained from R12, R14 and R16 which set both the zero and scale factor of the thermometer. When the transducer is turned off, a continuous output is provided by C3 and Q4. Resistor R15 decreases the circuit's sensitivity to MOSFET gm, allowing almost any MOSFET to be used. About 2.0V should be dropped

across R15 at full scale output. R8 is used to trim the thermometer, correcting for zener tolerance, temperature error in the sensor and resistor tolerance. With the values shown, a 0 to 50 μ A output is obtained for a +50°F to +100°F temperature change. Other ranges can be selected by using the formulas shown in the box on the circuit diagram.

The low power consumption makes this thermometer especially attractive for battery operated equipment. Further, the current source output allows long lines to be driven with no loss of accuracy. Finally, the circuit is easy to set up for almost any desired temperature range.

General Purpose Power Supply

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INTRODUCTION

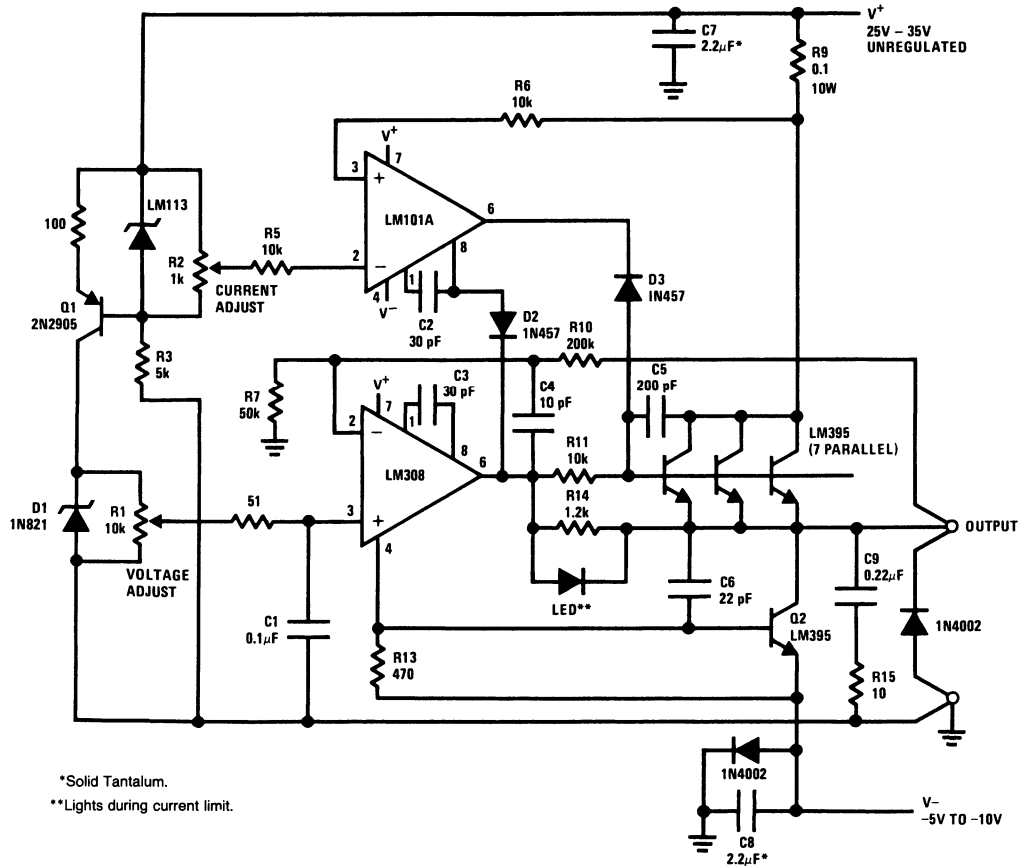
A general purpose lab type constant voltage/constant current power supply is easily made using standard integrated circuits. The circuit shown will provide up to 25V at up to 10A output with both the output voltage and current adjustable down to zero. Although relatively simple, very high performance is obtained.

Lab supplies must withstand considerable abuse. Good control of maximum output current is mandatory both to protect the supply and the powered circuitry. One of the shortcomings of many commercial supplies is the use of a large output capacitor to help frequency compensate the regulator loop. This output capacitor can discharge many times the peak output current of the supply into the load as well as degrade the ac output impedance when the supply is used as a constant current source. (Of course, the output capacitor helps keep the ac output impedance low when the sup-

ply is used as a constant voltage source.) The circuit shown has good response both as a constant voltage or constant current source.

The use of the LM395 monolithic power transistor as the pass element considerably simplifies the design power. The LM395 acts as a 2A current limited, thermally limited, high gain power transistor. Since only a maximum of $10\ \mu\text{A}$ is needed to drive the pass elements and complete overload protection is included on the chip, external biasing and protection circuitry is minimized. Only two control op amps are needed—one for voltage control and one for current control.

In constant voltage operation, a reference voltage is fed from voltage control pot, R1, through a high frequency filter into the non-inverting input of an LM308 op amp. The output of the LM308 drives seven paralleled LM395's as emitter followers to obtain a 10A capability.



TL/H/8477-1

Feedback is taken through R10 directly from the output with the overall gain set at 5 by the ratio of R10 to R7. An additional LM395 is driven from the negative power supply lead of the LM308 to provide some output current sink capability (2A) so the supply can be quickly programmed even with large capacitive loads. Frequency compensation is achieved with C3 for the LM308 and C4 for the overall loop. Resistor R11, capacitors C5 and C6 and network R15-C9 suppress parasitic high frequency oscillations.

When the circuit is used in the constant current mode, the LM101A overcomes the constant voltage loop to control the output. Output current is sensed in R9 and compared with the voltage between V^+ and the arm of R2. R2 is connected across an LM113 low voltage reference diode to provide a 0V to 1.2V reference for 0A to 12A output. When the output current is below the set level, the LM101A output is

positive, reverse biasing D3 and the LM308 control the output. When the current increases to the control point the output of the LM101A swings negative and decreases the drive to the output pass devices through D3, limiting the current. (Note that no separate positive supply is needed since the common mode operative range of the LM101A is equal to the positive supply.) Diode, D2, clamps the output of the LM101A when it is not regulating, decreasing the switchover time from voltage to current mode operation.

A few special precautions are needed in construction for proper operation. All LM395's should be mounted on the same heat sink to insure good current sharing. Also, a large heat sink is necessary since 300W will be dissipated under worst case conditions. Since the LM395's are high devices, the supply bypasses should be near the power transistors.

Low Cost AM Radio System using LM3820 and LM386

National Semiconductor
 Linear Brief 29
 Elias S. Papanicolaou



INTRODUCTION

The majority of linear integrated circuits being produced today is in the field of op amps, comparators and regulators. This has come about for the reason that these types of devices can take advantage of the well matched characteristics of monolithic components. However, in recent years the monolithic integrated circuit has found its place in communication systems such as radios and televisions. The basic philosophy in this area, and the consumer industry as a whole, has mainly been cost reduction over discrete counterparts, improved performance and higher reliability.

An integrated circuit which meets the above criteria is the LM3820 AM-RADIO SYSTEM, designed primarily for super-heterodyne AM receiver applications utilizing an RF-amplifier stage ahead of the mixer-oscillator. However, this

linear brief describes how the LM3820 and LM386 can be incorporated in the design of a conventional low cost AM-radio without an RF-amplifier stage.

RADIO DESCRIPTION

The block diagram of the radio is depicted in *Figure 1*. A complete schematic is shown in *Figure 2*. The building blocks for the Mixer-Oscillator, the two IF stages, and the AGC section, are contributed by the LM3820. Power output of 1/4W into an 8Ω speaker is obtained by the LM386, the gain of which is externally set to 200. The LM3820 is operated from a 6V supply, that is, below the voltage of zener diode D6, see *Figure 3*.

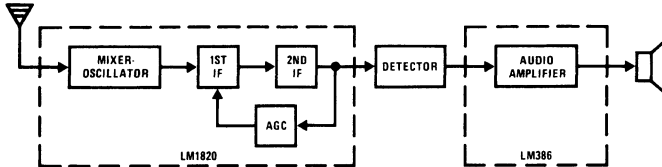


FIGURE 1. Radio Block Diagram

TL/H/8732-1

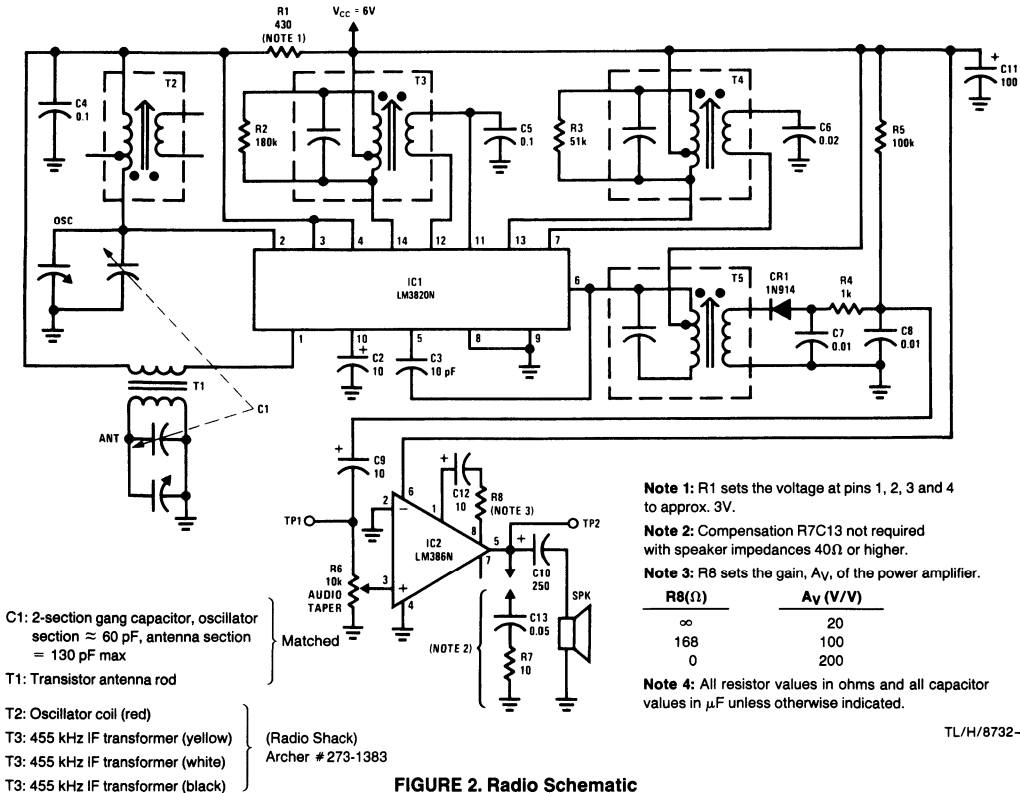


FIGURE 2. Radio Schematic

TL/H/8732-2

Pins 1, 2, 3 and 4 are biased from the same supply through a 430Ω dropping resistor. This reduces the total current consumption to approximately 10 mA making the operation from a 6V battery feasible. The dc return of pin 1 and 4 to pin 3 improves component count and prevents transistor Q4 in the oscillator section from saturating. Large swings are preserved by returning the collectors at pins 14, 13 and 6 to V_{CC} via the primary windings of transformers T3, T4 and T5 respectively. For better linearity, detector diode 1N914 is biased slightly in the forward direction. Radio performance concerning distortion, AGC, sensitivity and signal-to-noise is shown in Figure 4. These data are taken with the radio laid out as shown in Figure 5.

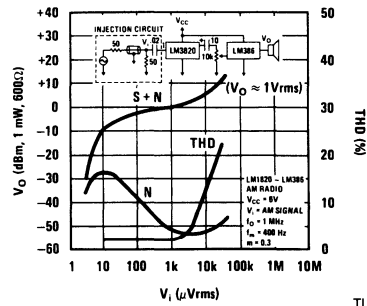


FIGURE 4. Radio Performance Plots

TL/H/8732-4

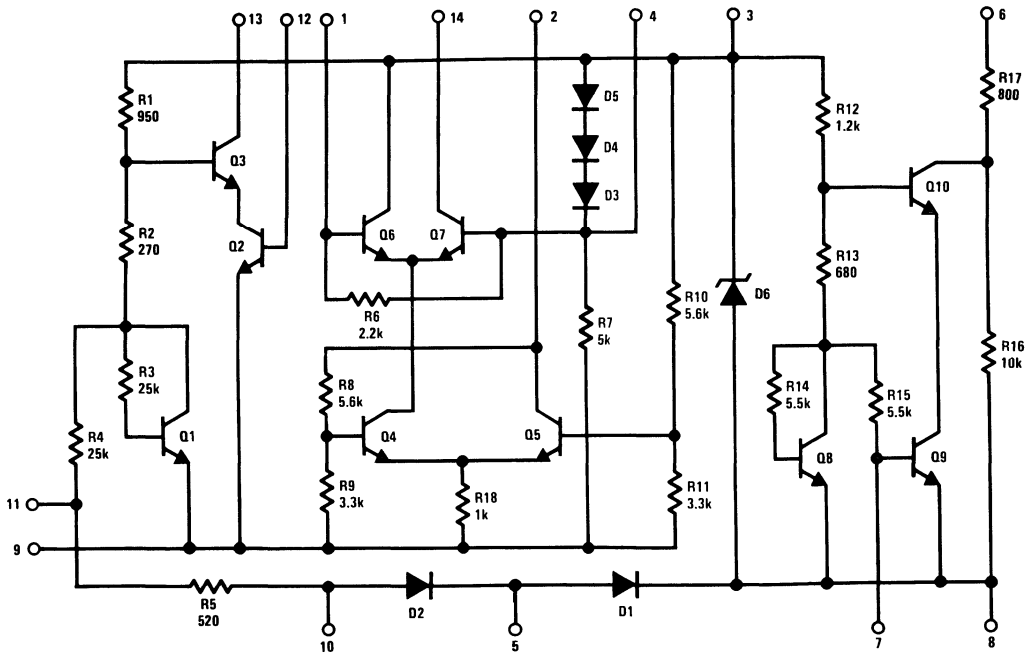


FIGURE 3. LM3820 Schematic

TL/H/8732-3

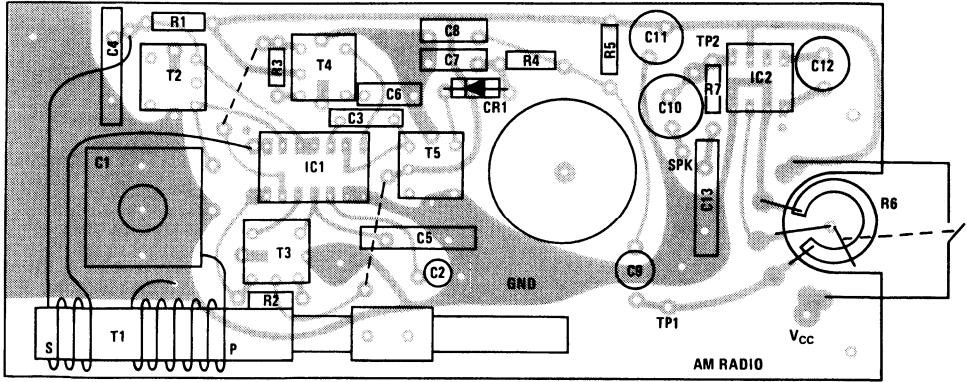


FIGURE 5. Typical Printed Circuit Board Radio Layout (Bottom View) (Not Shown Full Size)

TL/H/8732-5



INTRODUCTION

Comparison of dc signal levels within microvolts of each other can be made by using an LM121A pre-amp and an LM111 comparator IC. Implementing this with two separate IC's decreases noise, eliminates troublesome thermal effects, and achieves a maximum offset drift of $0.22 \mu\text{V}/^\circ\text{C}$ (Figure 1).

Designing a practical comparator with a voltage gain of 10 million involves protecting the *input* stage from temperature changes or gradients, and avoiding problems of including the noise filter within the positive feedback loop. The circuit as shown has a $5 \mu\text{V}$ hysteresis which can be trimmed to $1 \mu\text{V}$ under certain conditions. Further, delays *decrease* with increasing overdrive (see chart) due to elimination of input stage thermal effects, saturating stages, and dielectric soak or polarization effects on signal filter capacitors (Table I).

DESIGNING WITH A PRE-AMP

With the bias network shown, the LM121A input stage has an open-loop temperature stable voltage gain of close to 100. The 100k output impedance of the LM121A is shunted by C_S to filter out pickup and internally generated noise. No feedback to the inputs of the pre-amp is employed to avoid degrading common-mode rejection of the system.

The separate pre-amp with a gain of 100 provides two major advantages over single comparator designs. First, V_{OS} and other small errors attributed to the LM111 are reduced by the 100 gain factor. More important, temperature gradient changes which occur within the LM111 when switching any output load, are completely isolated by the separate packages and do not affect the pre-amp. If the entire microvolt comparator were on a single silicon chip, a temperature variation of as little as $1/1000^\circ\text{C}$ across the input stage could have a significant effect.

TABLE 1. Typical Overdrive Delays

Hyst. Set	R_H	R_S	C_S	Delays with Various Overdrives			
				25%	100%	1000%	100 mV
$5 \mu\text{V}$	$75 \text{ k}\Omega$	$10 \text{ k}\Omega$ Max.	6800 pF	2 ms	1.8 ms	$600 \mu\text{s}$	$560 \mu\text{s}$

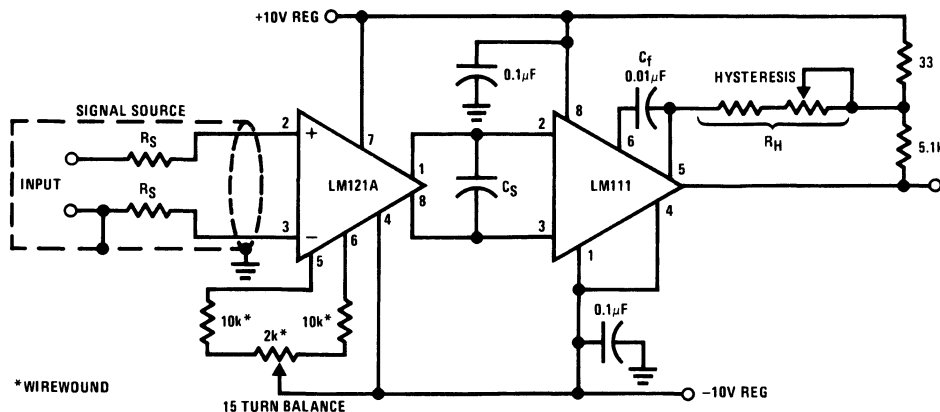


FIGURE 1. Schematic Diagram

TL/H/8733-1

This effect is a major reason for designing circuits sensitive and stable to microvolt dc signals with a *separate* pre-amplifier. Further, the special 4-transistor input stage, when adjusted to zero offset with the "balance" control between pins 5 and 6, automatically reduces V_{OS} change with temperature to almost zero.

FILTERING

The pre-amp/comparator system generates a continuous stream of very fast pulses if assembled without a filter, even with positive feedback for hysteresis. This is caused by both stray output-input feedback, and noise. The noise is both thermal and pickup from the environment, including power switching transients and fluorescent light hash. To cure this, shunt filter capacitor C_S is used.

Placing this capacitor outside the positive feedback loop has two advantages. It eliminates a tendency for the comparator to oscillate during slow transitions. Also, response time to small signals is halved since the positive hysteresis feedback signal is not stored on the filter capacitor.

A higher frequency filter (C_f) is needed to provide a low impedance shunt to any high frequency noise and stray feedback that may be picked up between LM111 terminals 5 and 6. These two terminals have almost the same voltage sensitivity as the normal input terminals. The positive feedback to terminal 5, as described below, is only delayed slightly by this filter.

FEEDBACK

The positive feedback provided by the $5.1k/33\Omega$ voltage divider with R_H is needed to insure clean, rapid changes of state. It is applied to one of the "balance" terminals (pin 5) of the LM111 to simplify the circuit over a balanced feedback network, and to minimize signal stored on C_S as previously described. The current fed back to terminal 5 is single ended with respect to the balance adjust network between these terminals, and hence injects a dc offset of the desired polarity and amplitude for a few microvolts of latching.

PERFORMANCE

A tabulation is shown for one of the many possible combinations of input circuits, filters, etc. For large amplitude signals, C_S can be decreased and hysteresis increased for greater speed. Conversely, to obtain hysteresis as low as $1 \mu V$, trim R_H (to about 300k) use a C_S of $0.01 \mu F$ to $0.1 \mu F$ and have a low impedance source of signals.

For reduced ambient range and drift specifications, an LM321 can be paired with the LM311 for a cost saving while maintaining the same comparison sensitivity.

DESIGN TIPS FOR MICROVOLT SIGNALS

Even with high performance devices such as the LM121, microvolts of error can occur from thermocouple effects, common-mode signals, "microphonics," or unbalances in the input or nulling circuits. As pointed out in Application Note AN-79, Kovar lead to copper circuit board thermocouple effects can cause a $3.5 \mu V$ offset voltage for only $0.1^\circ C$ difference across the input leads. A compact layout of input connections and shielding from air currents will minimize this problem.

Although the LM121A has excellent common-mode rejection (> 120 dB), a 1V change in common-mode voltage can induce up to $1 \mu V$ of error voltage. For this reason common-mode voltage changes should be kept to a minimum. Also, common-mode voltages allow mechanical vibrations in the probe cable to induce "microphonic" noise signals. Short, stiff, low capacitance and symmetrical input shielded wires are recommended.

If it is possible to have a signal source balanced with regard to ground, it will help decrease errors due to bias currents, and noise due to common-mode and microphonic effects. Matched, low temperature coefficient parts should be used in the balance network, and care should be exercised in shielding input circuits and eliminating ground-loops.

APPLICATIONS

The microvolt comparator is particularly well suited to controllers or test equipment having thermocouples or strain gauges as inputs. This includes wind speed indicators, RMS to dc converters, vacuum gauges, gas analysis equipment, conductivity gauges, and hot wire controls. The strain gauges can be used in materials testing, electronic weighing, pressure transducers, and load limiting sensors for cranes, hoists, and rolling mills.

As a temperature controller, $\frac{1}{8}$ degree or less on-off differential can be obtained using thermocouple types E, J, T or K. Other microvolt signals used for control may come from Hall effect sensors, Bolometers, slide-wires, and heat-flow thermopiles. A microvolt comparator will be useful in "Go/No-Go" testing of low resistances such as switch and relay contacts, RTDs, coil and fuse resistances, and pressure-sensitive-plastic conductors.

A Micropower Voltage Reference

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LB-34

A low-drift voltage reference can be easily made by converting a zero temperature coefficient current to a voltage. JFETs biased slightly below pinch-off exhibit a zero temperature coefficient drain current (I_D) as shown in *Figure 1*. With the above property and a micropower operational amplifier, used to convert the drain current to a voltage, a low power consumption voltage reference can be built as shown in *Figure 2*. The consumption of LM4250 op amp is programmed through resistor R_{SET} . Potentiometer P1 should be adjusted for low output (V_{REF}) temperature coefficient. Actually, it can be trimmed for positive, negative or zero temperature coefficient. The output voltage is trimmed through P2 and it is expressed by:

$$V_{REF} = I_{D1} (P_2 + R_1 + R_2),$$

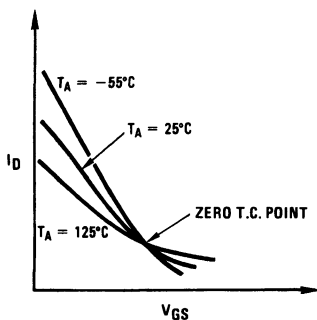
$$R_2 = R_3, I_{D1} \cong I_{DSS} \left[1 - \frac{V_{GS}}{V_p} \right]^2$$

With the values shown in *Figure 2*, the temperature coefficient of the output is 0.002%/°C and the overall standby

current less than 100 μ A. The characteristics of the LM4250 are a function of its supply current, which depends on R_{SET} , and V^+ . V^+ can be provided by V_{REF} through the addition of a second FET, J2, shown in *Figure 3*. This way the parameters of the op amp will be independent of the unregulated input. The reference voltage can be taken from the wiper of the potentiometer P2 ($V_{REF} = V^+$) or from the source of J2 ($V_{REF} > V^+$). In the first case, the output impedance of the circuit is quite high and buffering may be required according to the application. The output impedance in the second case is low, essentially the 1/gm of (J2) divided by the loop gain of the circuit. In this case, a small temperature coefficient due to the supply current of the LM4250 is going to be added and be compensated for by an additional trimming of P1. V_{REF} is computed by:

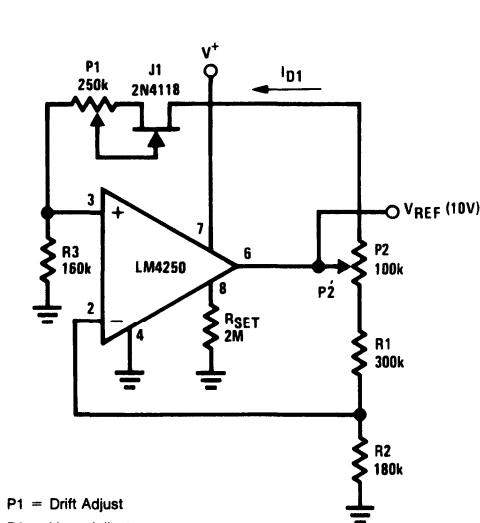
$$V_{REF} \cong I_{D1} [P_2 + R_1 + R_2] + P_2' [I_S + I_{D1}],$$

$$R_2 = R_3, I_S \cong \frac{6(V^+ - V_{BE})}{R_{SET}}$$



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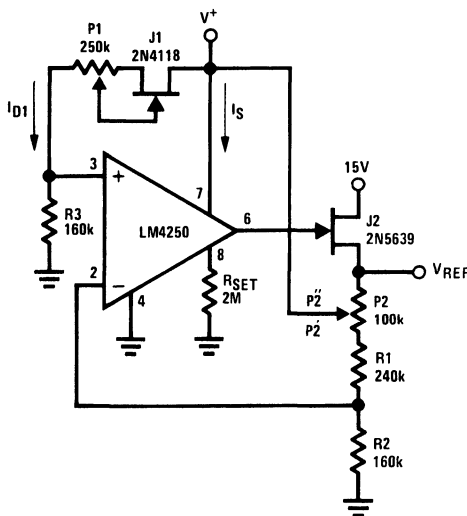
FIGURE 1. FET Transfer Characteristics



P1 = Drift Adjust
P2 = V_{REF} Adjust

TL/H/8734-2

FIGURE 2. Basic Voltage Reference



TL/H/8734-3

FIGURE 3. Improved Voltage Reference

Adjustable 3-Terminal Regulator for Low-Cost Battery Charging Systems

National Semiconductor
Linear Brief 35



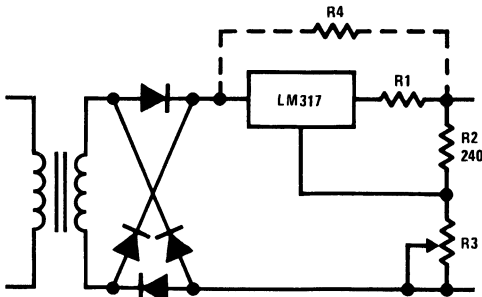
With the introduction of the LM317, a 3-terminal adjustable regulator, it becomes relatively easy to design high-performance, low-cost battery charging systems. Even single battery cells can be charged on this new regulator, which is adjustable down to 1.2V. The internal protection circuitry can be used to limit charging current as well as to protect against overloads. The output voltage is easily adjusted so multiple voltage chargers can be made.

The ability to accurately adjust the output voltage of the LM317 makes it especially attractive for constant voltage battery charging applications. Batteries are most quickly charged by "constant-voltage" charging circuits; however, close control of the charging voltage is necessary to prevent overcharging, especially with nickel cadmium cells. The internal protection circuitry of the LM317 is helpful in protecting against accidental overload conditions commonly occurring in charging systems.

INTERNAL CURRENT LIMIT

The peak charging current or output current is controlled by the internal current limit of the LM317. This current limit will work even if a battery is connected backwards to the output of the charger. Should a fault condition exist for an extended period of time, the thermal limiting circuitry will decrease the output current, protecting the regulator as well as the transformer. A constant voltage charger circuit is shown in *Figure 1*. The output voltage is set with resistors R2 and R3 and given by

$$V_{OUT} = 1.25 \left(1 + \frac{R3}{R2} \right)$$



TL/H/8484-1

FIGURE 1. Constant Voltage Charging Circuit

Since, in low cost applications, no filter capacitors are used on the output of the rectifier, the battery is only charged on the peaks of the sine wave. This requires the peak output voltage from the transformer to be at least 50% greater than the battery voltage plus 3V. However, little cost premium should result since the average current from the transformer is lower than capacitive input filter circuits. Optional resistors R1 and R2 are used to further control the charging characteristics. Resistor R1 controls the output impedance of the charger allowing a "taper-charge" characteristic to be

generated. The LM317 can also be used to limit the peak charging current to a partially charged battery at a value other than the regulator current limit. With R1 in the circuit, the output impedance is:

$$Z_{OUT} = R1 \left(1 + \frac{R3}{R2} \right)$$

Including R1 in the feedback loop decreases the value of resistor needed for a particular output impedance reducing cost and power dissipation.

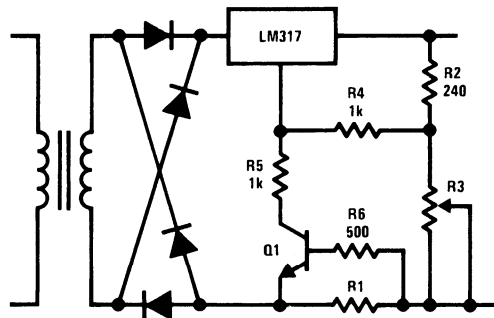
For example, with a 6V gelled electrolyte battery the regulator can be set to give a 6.9V output. Nominally, the battery is discharged to about 5V, making R1 0.4Ω output impedance and limiting the charging current to 0.5A at the start of charging rather than the internal current limit of the regulator. With a fully discharged battery or under short circuit conditions, the peak output current is still 2A for the LM317K with the resistor dissipating 1.6A as opposed to 8W if a 2Ω resistor were used directly in series with the battery.

Resistor R4 can be included to provide a low "topping-up" current for a charged battery.

This regulator configuration provides some other important features to the charger. If input power is removed and a fully charged battery is connected to the charger output, there is no damage. Under these conditions about 5 mA of current will be drawn by divider R2, R3. Since there is no ground connection to the LM317 regulator, very little current flows through the LM317. In this respect, the LM317 differs from other 3-terminal regulators, which can be damaged by applying power to the output terminal with the input open-circuited. If the battery is connected backwards, the LM317 will current limit and thermal limit normally, protecting the charger.

DECREASING CURRENT LIMIT

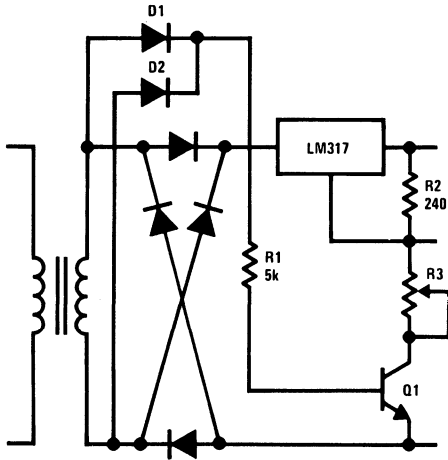
Adding a single NPN transistor can be used to decrease the current limit of the charge as shown in *Figure 2*.



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FIGURE 2. Constant Voltage Charger with Peak Current Limiting

Resistor R1 senses the output current and turns on Q1 when I_{OUT} R1 equals about 0.6V. Transistor Q1 pulls the adjustment terminal negatively decreasing the output voltage and controlling the output current. A limitation of this circuit is that it does not work for direct short circuits. The output voltage must be above about 0.6V for the external current limiting to be active. The internal current limit of the LM317, of course, is still operative. This is not usually a problem since batteries charge to above 0.6V very quickly. Resistors R4, R5 and R6 protect the regulator and transistor for both direct short circuits or reverse battery connections.

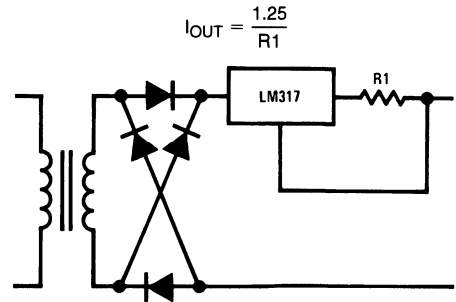


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FIGURE 3. Charger with No Battery Loading when Power is "OFF"

As illustrated in *Figure 3*, in float or standby applications, it is desirable to remove all loading from the battery when input power is "OFF." When power is "ON," Q1 is saturated, grounding the voltage setting divider R2, R3 and the circuit works in a similar manner to the charger circuit in *Figure 1*. When power is "OFF," Q1 is open, eliminating any loading on the battery. A separate pair of low current diodes D1, D2 are necessary to bias Q1, rather than the power bridge rectifier. If R1 was tied to the output of the bridge, reverse current flow through the LM317 would keep Q1 "ON" and loading the battery.

A simple constant current charger for any type of battery is shown in *Figure 4*. A resistor R1 between the adjustment terminal and the output of the regulator sets the output current at:



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FIGURE 4. Constant Current Charger

Current can be set at anywhere between 10 mA and 1.5A by appropriate resistor choice. Current regulation is very tight at any current level since only 50 μ A flows out of the adjustment terminal. This circuit is also immune to damage from shorts or reverse battery connections. The input voltage for regulation should also be about 1.5 times the battery voltage plus 3V.

UNIQUELY SUITED

The ability to adjust the output of the LM317 3-terminal regulator makes it uniquely suited for battery charging systems. Little has been included about charging specific types of batteries, since the characteristics of the charger should be matched to the battery. These charger circuits, although very simple, perform well. They are easily modified for voltage, current or even temperature coefficient by making the divider string temperature sensitive. More complex chargers can be made since the output of the LM317 is easily controlled by driving the adjustment terminal. Finally, the chargers are inherently protected against overloads and fault conditions.

Wide Range Timer



One of the problems encountered in potentiometer controlled circuits is dynamic range. With a linear pot, about a 100:1 range is the limit. Although the pot resolution may be better than 1%, the angular displacement for good control becomes too small. Usually, range switching is then used.

A logarithmic control is a possible solution. With log controls, the resolution is the same anywhere within the operating range. For example, if 40° rotation is equal to a change from 10% to 100% of full scale, then 40° rotation is also equal to a change from 0.01% to 0.1% of full scale. It is easy to control a function over a 1,000,000:1 range with good control anywhere within the range.

The exponential relationship between the emitter-base voltage of a transistor and its collector current is well known. This relationship holds true within a few percent over extremely wide ranges. Using a transistor pair, and an op amp, it is easy to make a current source controllable over a 6 decade range.

Figure 1 shows a timer which can be adjusted from 2 ms to 2000 seconds with a single control. An LM122 is used for the timing function in conjunction with a current source that is logarithmically controlled from a pot. The operation is as follows:

Transistors Q1 and Q2 are a matched PNP pair. Resistor R1 and the op amp set up a constant current of 1 mA through Q1 using the internal 3V reference from the timer. With R2 at the most positive end of its range, the non-inverting input

of the op amp is a V_{REF} . This forces the emitter-base voltage of Q2 to equal Q1 and since the transistors are matched, the collector current of Q2 is also 1 mA. A time-out period of 2 ms results.

Rotating R2 subtracts the voltage between the arm of the pot and V_{REF} from the emitter-base voltage of Q2—lowering its collector current. The current is decreased by a factor of 10 for every 60 mV developed. A total of 360 mV is dropped across the pot, allowing a reduction in Q2 collector current by a factor of 1,000,000 or from 1 mA to 1 nA. A 1 nA charging current gives a 2000 second time out. (At maximum time, there is about a 30% error due to the 0.3 nA input current of the comparator). Finally, diodes D1 and D2 temperature compensate the voltage across the pot.

Calibrating the circuit is relatively easy (except for obtaining a log dial for the pot). Resistor R1 is adjusted for the minimum operating time removing for mismatch in the transistors, capacitor tolerance, and the offset of the op amp. R3 is used to calibrate the full scale time by adjusting the drop across R2 to 360 mV.

This type of log control is not limited to timers. If used in oscillator or function generator circuits, an ultra wide range VCO can be made. Also, in power supply circuitry, it is possible for a regulator to have as much resolution when adjusted for 0.001V output as when the output is 10V. Finally, a log current generator makes an easily adjusted low value current source without high value resistors.

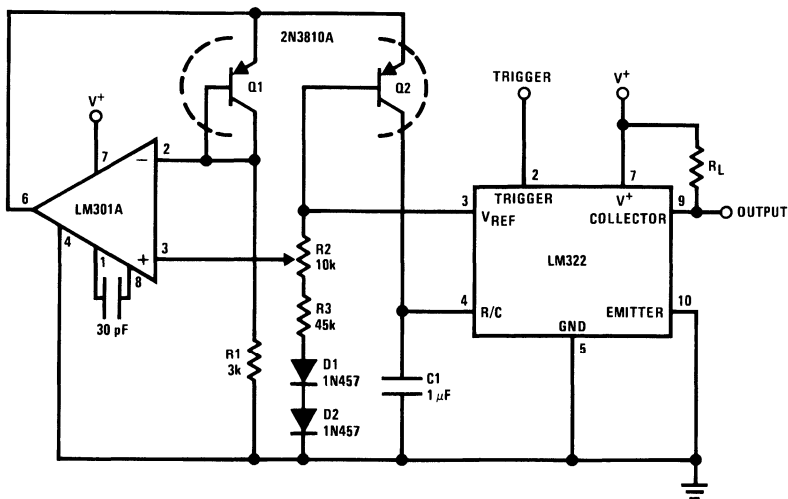


FIGURE 1. 2 ms to 2000 Second Timer

TL/H/8487-1

Circuit Techniques for Avoiding Oscillations in Comparator Applications

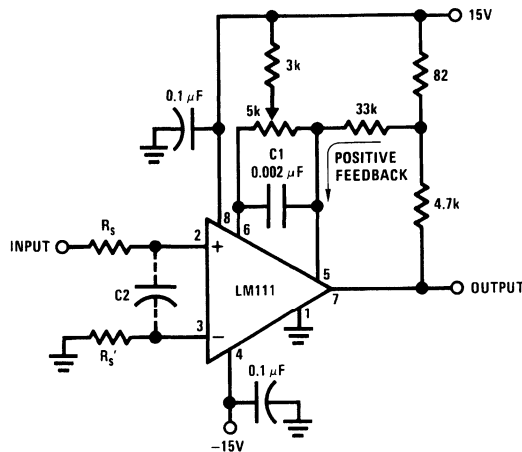
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When a high-speed comparator such as the LM111 is used with fast input signals and low source impedances, the output response will normally be fast and stable, assuming that the power supplies have been bypassed (with $0.1 \mu\text{F}$ disc capacitors), and that the output signal is routed well away from the inputs (pins 2 and 3) and also away from pins 5 and 6.

However, when the input signal is a voltage ramp or a slow sine wave, or if the signal source impedance is high ($1 \text{ k}\Omega$ to $100 \text{ k}\Omega$), the comparator may burst into oscillation near the crossing-point. This is due to the high gain and wide bandwidth of comparators like the LM111. To avoid oscillation or instability in such a usage, several precautions are recommended, as shown in *Figure 1* below.

1. The trim pins (pins 5 and 6) act as unwanted auxiliary inputs. If these pins are not connected to a trimpot, they should be shorted together. If they are connected to a trim-pot, a $0.01 \mu\text{F}$ capacitor C1 between pins 5 and 6 will minimize the susceptibility to AC coupling. A smaller capacitor is used if pin 5 is used for positive feedback as in *Figure 1*.
2. Certain sources will produce a cleaner comparator output waveform if a 100 pF to 1000 pF capacitor C2 is connected directly across the input pins.
3. When the signal source is applied through a resistive network, R_s , it is usually advantageous to choose an R_s' of substantially the same value, both for DC and for dynamic (AC) considerations. Carbon, tin-oxide, and metal-film resistors have all been used successfully in comparator input circuitry. Inductive wirewound resistors are not suitable.
4. When comparator circuits use input resistors (e.g. summing resistors), their value and placement are particularly important. In all cases the body of the resistor should be close to the device or socket. In other words there should be very little lead length or printed-circuit foil run between comparator and resistor to radiate or pick up signals. The same applies to capacitors, pots, etc. For example, if $R_s = 10 \text{ k}\Omega$, as little as 5 inches of lead between the resistors and the input pins can result in oscillations that are very hard to damp. Twisting these input leads tightly is the only (second best) alternative to placing resistors close to the comparator.
5. Since feedback to almost any pin of a comparator can result in oscillation, the printed-circuit layout should be engineered thoughtfully. Preferably there should be a groundplane under the LM111 circuitry, for example, one side of a double-layer circuit card. Ground foil (or, positive supply or negative supply foil) should extend between the output and the inputs, to act as a guard. The foil connections for the inputs should be as small and compact as possible, and should be essentially surrounded by ground foil on all sides, to guard against capacitive coupling from any high-level signals (such as the output). If pins 5 and 6 are not used, they should be shorted together. If they are connected to a trim-pot, the trim-pot should be located, at most, a few inches away from the LM111, and the $0.01 \mu\text{F}$ capacitor should be installed. If this capacitor cannot be used, a shielding printed-circuit foil may be advisable between pins 6 and 7. The power supply bypass capacitors should be located within a couple inches of the LM111. (Some other comparators require the power-supply bypass to be located immediately adjacent to the comparator.)
6. It is a standard procedure to use hysteresis (positive feedback) around a comparator, to prevent oscillation, and to avoid excessive noise on the output because the



Pin connections shown are for LM111H in 8-lead TO-5 hermetic package

FIGURE 1. Improved Positive Feedback

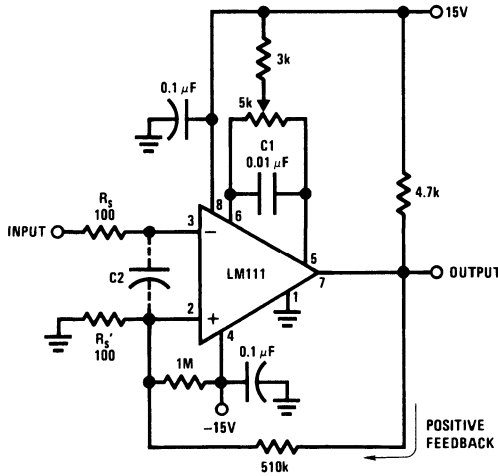
TL/H/8488-1

comparator is a good amplifier for its own noise. In the circuit of *Figure 2*, the feedback from the output to the positive input will cause about 3 mV of hysteresis. However, if the value of R_s is larger than 100Ω , such as $50\text{ k}\Omega$, it would not be reasonable to simply increase the value of the positive feedback resistor above $510\text{ k}\Omega$. The circuit of *Figure 3* could be used, but it is rather awkward. See paragraph 7, below, for the alternative.

7. When both inputs of the LM111 are connected to active signals, or if a high-impedance signal is driving the positive input of the LM111 so that positive feedback would be disruptive, the circuit of *Figure 1* is ideal. The positive feedback is to pin 5 (one of the offset adjustment pins). It is sufficient to cause 1 to 2 mV hysteresis and ensure

sharp output transitions with input triangle waves from a few Hz to hundreds of kHz. The positive feedback signal across the 82Ω resistor swings 240 mV below the positive supply. This signal is centered around the nominal voltage at pin 5, so this feedback does not add to the V_{OS} of the comparator. As much as 8 mV of V_{OS} can be trimmed out, using the $5\text{ k}\Omega$ pot and $3\text{ k}\Omega$ resistor as shown.

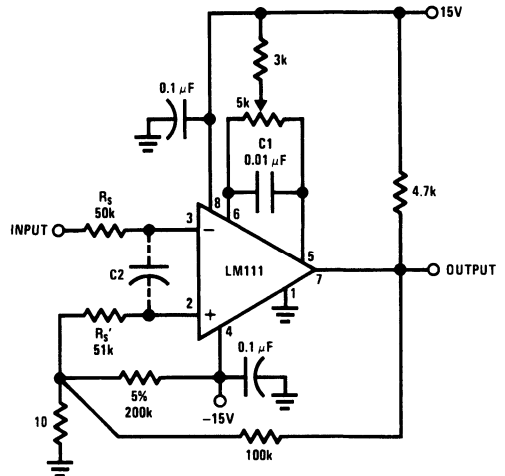
8. These application notes apply specifically to the LM111, LM211, LM311, and LF111 families of comparators, and are applicable to all high-speed comparators in general, (with the exception that not all comparators have trim pins).



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Pin connections shown are for LM111H in 8-lead TO-5 hermetic package

FIGURE 2. Conventional Positive Feedback



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FIGURE 3. Positive Feedback with High Source Resistance

Two Wire Current Transmitters

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Transmitting analog information from remote points is not easy. Line resistance and ground loop voltages tend to degrade accuracy unless special precautions are taken.

The most common method of signal transmission is to use a 4-wire system. Two wires are used for power to the remote station and 2 wires are used to return the signal. At the receiving end, a high input impedance differential amplifier is used to eliminate the effects of ground loop voltages. By transmitting power and signal over the same wires, system cost is reduced.

The system shown here can accurately transmit data over long distances, with a minimum of problems. Rather than transmit the data as voltage, a precise current is used. Further, the system needs only 2 leads. Remote-station power and analog information are transmitted over the same 2 wires.

Figure 1 shows a simple 2-wire current transmitter. An LM304 voltage regulator is used as a specialized op-amp for current control. The LM304 has an op-amp, output stage and voltage reference which make it especially suitable for this application. The op-amp input and output stage will operate with common-mode voltages equal to the positive supply voltage.

The inverting input, positive supply, and outputs (pins 7, 8 and 9) are tied together. This forces the total device current to flow through R3. The input signal is applied through R5 to the non-inverting input. Since the current into the non-inverting input is negligible, an input voltage causes a current flow through R5 equal to

$$I = \frac{V_{IN}}{10 \text{ k}\Omega}$$

This same current flows through R2 and causes the input voltage to also appear across R2. The LM304 forces the voltage between pins 1 and 7, 8 and 9 to be equal so the input voltage also appears across R3 with a resulting current of

$$\frac{V_{IN}}{R3}$$

The total current from the supply is drawn through R2 and R3 is therefore well defined and easily calculated.

$$I_{SUPPLY} = \frac{V_{IN}}{R5} \left[1 + \left(\frac{R2}{R3} \right) \right] + \frac{2.4V}{R1} \left[1 + \left(\frac{R2}{R3} \right) \right]$$

Since the LM304 must draw some supply current, the output current for zero input signal must be greater than zero. This zero signal current is set by R1 from the internal reference

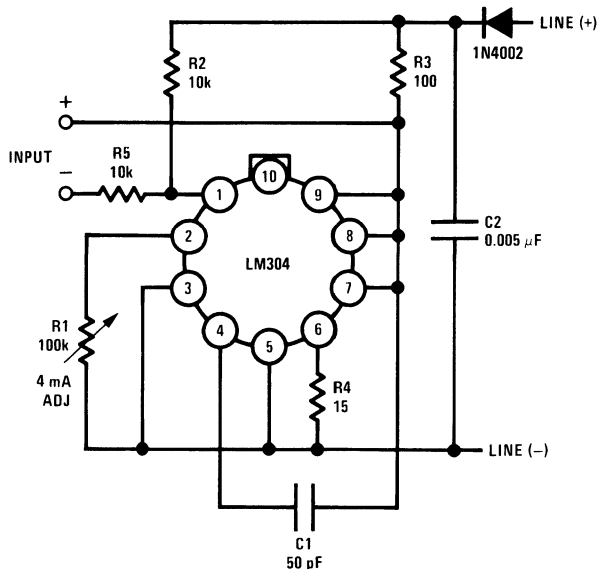


FIGURE 1. Basic Current Transmitter

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Precision Reference Uses Only Ten Microamperes

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Increasing interest in battery-operated analog and digital circuitry in recent years has created the need for a micro-power voltage reference. In particular, the reference should draw 10 μA or less and operate from a single 5V supply. These requirements eliminate zener diodes which tend to have unpredictable temperature drift and are noisy at low currents and low voltages. One possibility is the LM103 series of punch-through diodes which have break-down voltages of 1.8V to 5.6V and operate well at 10 μA . Unfortunately, these devices drift at $-5 \text{ mV}/^\circ\text{C}$ and extra circuitry must be added to create a low-drift reference. Non-linearity in the drift characteristic limits usable drift compensation to about 50 ppm/ $^\circ\text{C}$. Variations in slope from device to device can be up to $\pm 0.5 \text{ mV}/^\circ\text{C}$, so each reference must be individually corrected for temperature drift in an oven test.

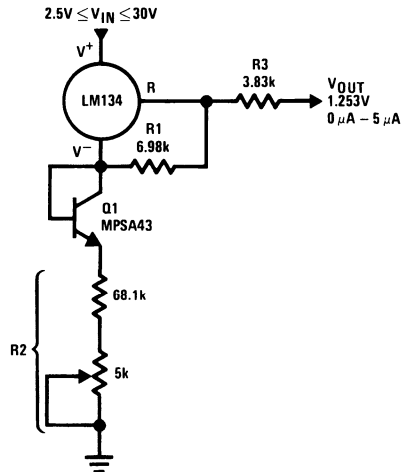
The LM134 current source can provide an interesting solution to the low-power-drain reference problem. This device is a 3-terminal current source which has a compliance of 1V to 40V and is programmable over a current range of 1 μA to 10 mA. Current is determined by an external resistor. With a zero drift resistor, the LM134 current is directly proportional to absolute temperature ($^\circ\text{K}$). Untrimmed accuracy of the current is $\pm 3\%$, but the key to the success of the LM134 is that initial errors are gain errors which are trimmed to zero when the external resistor is adjusted. Independent of initial current, if the current is adjusted to 298 μA at $T = 25^\circ\text{C}$ (298 $^\circ\text{K}$), all devices will have a current dependence of $1 \pm 0.01 \mu\text{A}/^\circ\text{C}$.

A voltage reference can be made by combining the positive temperature coefficient of the LM134 with the negative TC of a forward-biased diode. The IC terminology for such a reference is "bandgap reference" because the total voltage of the reference is equal to the extrapolated (0 $^\circ\text{K}$) bandgap voltage of silicon. An important characteristic of bandgap references is that the zero TC voltage is independent of diode current even though the diode voltage and TC are not. This means that by adjusting the total voltage of the reference to a fixed value, T.C. will be adjusted to near zero at the same time. The zero TC voltage for most bandgap references falls between 1.20V and 1.28V.

The circuit in *Figure 1* is a micropower reference using the LM134 and an MPSA43 transistor connected as a diode with collector-base shorted. A transistor is used in place of a diode because the transistor characteristics as a double-diffused structure are more consistent than a diode. In particular, the emitter-biased voltage drift of wide-base high-voltage transistors connected as diodes is very linear with temperature.

In *Figure 1*, the LM134 controls the voltage between its R and V^- terminals to $\approx 64 \text{ mV}$. About 5.5% of the current out of the R terminal flows out of the V^- terminal. The total current flowing through R2 is then determined by $67.7 \text{ mV}/R1$. Output voltage is the sum of the diode voltage, plus the voltage across R2, plus 64 mV. The voltage TC across

R2 and the 64 mV is positive and directly proportional to absolute temperature while the diode TC is negative. The overall TC of the output will be near zero ($< 50 \text{ ppm}/^\circ\text{C}$) when the output is adjusted to 1.253V by trimming R2. To obtain this level of performance, R1 and R2 must track well over temperature. 1% metal film resistors are suggested.



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FIGURE 1

For optimum results with a single point adjustment of voltage and temperature coefficient, an additional error term must be accounted for. Internal to the LM134 are low I_{dss} FETs used for starting the control loop. This FET current adds directly to the V^- pin current and therefore creates an additional output voltage equal to $(I_{\text{dss}})(R2)$. Typical I_{dss} is 200 nA, causing V_{OUT} to be 14 mV high. Temperature coefficient of I_{dss} is low, typically 0.1%/ $^\circ\text{C}$. For best results in a single point adjustment, V_{OUT} should be adjusted to 1.253V + $I_{\text{dss}}(R2)$. I_{dss} can be easily measured by open circuiting R1 and measuring the drop across R2. The resulting voltage must be divided by 2 due to an internal action which causes 2 I_{dss} to flow when no current flows from the R pin. Example: with R1 open, 32 mV is measured across R2. Set V_{OUT} equal to $1.253\text{V} + 32 \text{ mV}/2 = 1.269\text{V}$. Even lower TC can be obtained by measuring the output at 2 temperatures and using the following formula to calculate the exact zero TC output voltage for each reference.

$$V_{\text{OUT}}(0 \text{ TC}) = V1 - \frac{T1(V2 - V1)}{T2 - T1}$$

Where:

V1 = Output voltage at T1

V2 = Output voltage at T2

T = Absolute temperature ($^\circ\text{K}$)

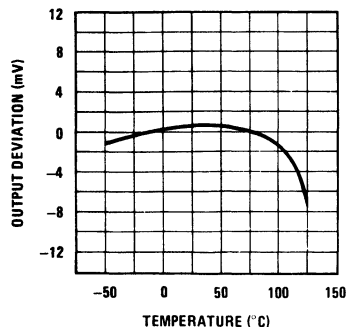
The limitation on temperature drift after a 2 point calibration is non-linearity. This reference circuit has a non-reducible bow error of ≈ 10 ppm/ $^{\circ}\text{C}$ over a temperature range of -25°C to $+100^{\circ}\text{C}$ and ≈ 5 ppm/ $^{\circ}\text{C}$ from 0°C to $+70^{\circ}\text{C}$. At 125°C , leakage creates significant error, causing the output voltage to droop about 5 mV.

Noise of the reference consists primarily of theoretical shot noise current from the LM134. At the $10\ \mu\text{A}$ level, this is about $6\ \text{pA}/\sqrt{\text{Hz}}$ rms from 10 Hz to 10 kHz. Total output noise would be $0.4\ \mu\text{V}/\sqrt{\text{Hz}}$ rms over this frequency range, except that C1 bypasses most of the noise above 2 kHz. Measured output noise was $25\ \mu\text{V}$ rms over a 10 Hz to 10 kHz bandwidth with $C1 = 1000\ \text{pF}$. Larger values of C1 may be used if lower broadband noise is needed. Low frequency noise is about $25\ \mu\text{V}$ peak-to-peak from 0.1 Hz to 10 Hz.

The LM134 has a negative output resistance at the R pin when resistance is inserted in series with the V^- pin. The value of this negative resistance is approximately $-R_X/19$, where R_X is the equivalent resistance from V^- to ground. In this reference circuit R_X is 72 k Ω , yielding a negative output resistance of 3.8 k Ω . Resistor R2 sums with this resistance to give the reference a net zero output resistance ($\pm 400\ \Omega$). Loading should be limited to about $5\ \mu\text{A}$. Line regulation for the reference is typically less than 0.5 mV with an input

voltage of $5\text{V} \pm 2\text{V}$. Minimum input voltage for a 2 mV drop in output voltage is 2.5V at -55°C , 2.4V at 25°C and 2.3V at 125°C .

Although this reference was designed for ultra-low operating current, there is no reason that it cannot be used at higher current levels as well. All resistor values are simply scaled downward. Higher operating current will give lower output resistance, more drive capability, less sensitivity to $FET\ I_{\text{dss}}$, lower noise, and less droop at 125°C .

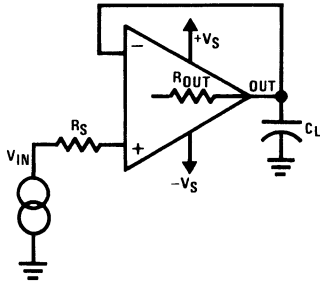


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FIGURE 2. Output Voltage Drift

Get Fast Stable Response From Improved Unity-Gain Followers

In many applications, a unity-gain follower (e.g. any operational amplifier with tight feedback to the inverting input) may oscillate or exhibit bad ringing when required to drive heavy load capacitance. For example, the LM110 follower will normally drive a 50 pF load capacitor, but will not drive 500 pF, because the open-loop output impedance is lagged by such a large capacitive load. The frequency at which this lag occurs is comparable to the gain-bandwidth product of the amplifier, and when the phase margin is decreased to zero, oscillation occurs.



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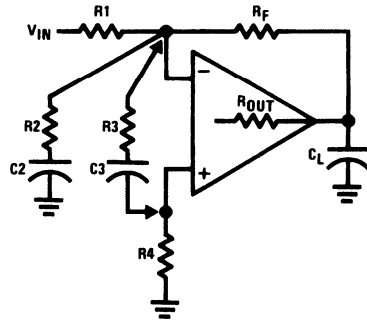
FIGURE 1. Unity-Gain Follower Attempting to Drive Capacitive Load

While the solution to this problem is not widely known, an analysis of the general problem shown in *Figure 2* can lead to a useful approach. It is generally known that increasing the noise gain of an op amp's feedback network will improve tolerance of capacitive load. In *Figure 2*, adding a resistor $R_2 \approx R_F/10$ will do this. (A moderate capacitor C_2 is usually inserted in series with R_2 , to prevent the DC noise gain from increasing also—to avoid degrading DC offset, drift and inaccuracy.) If the op amp has a 1 MHz gain bandwidth product, and $R_1 = R_F$, the closed-loop frequency response will be $\frac{1}{2}$ MHz. Adding $R_2 = R_F/10$ will drop the closed-loop frequency response to 90 kHz, where the amplifier can usually tolerate a much larger C_L :

$$\text{Noise Gain} = \frac{R_F}{R_1} + \frac{R_F}{R_2} + 1 \text{ (AC)}$$

$$\text{Noise Gain} = \frac{R_F}{R_1} + 1 \text{ (DC)}$$

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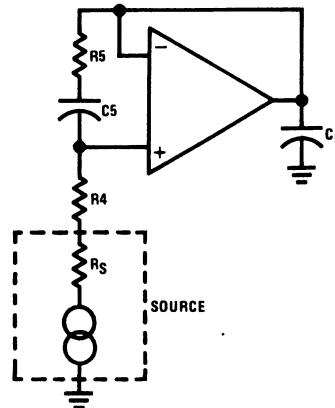
FIGURE 2. Stabilizing an Operational Amplifier for Capacitive Load

A similar result will occur if you install R_3 and C_3 , instead of R_2 . Now the (AC) noise gain will be:

$$1 + \frac{R_4}{R_3} + \frac{R_F}{R_3} + \left(\frac{R_F}{R_1} \right) \left(\frac{R_3 + R_4}{R_3} \right)$$

As a simplification, if R_1 is an open circuit, the AC noise gain will be: $(R_4/R_3 + R_F/R_3 + 1)$. Now it can be seen that noise gain can be raised by having a low value of R_3 and a high value of R_4 or R_F (or both).

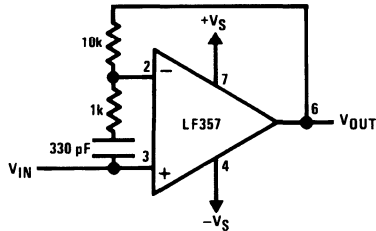
In particular, where R_F is required to be 0Ω , as in a follower, the noise gain can be raised by adding a large R_4 and a small R_5 , as shown in *Figure 3*. If R_S is low, the AC noise gain will be $R_4/R_5 + 1$. (If R_S is large and constant, R_4 may be unnecessary, and the noise gain would then be $R_S/R_5 + 1$.) For LM110/LM310's $R_4 = 10 \text{ k}\Omega$ is recommended and when $R_5 = 3.3 \text{ k}\Omega$, $C_5 = 200 \text{ pF}$, the LM110 will stably drive C_L up to 600 pF.



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FIGURE 3. Stabilizing a Unity-Gain Follower for Capacitive Load

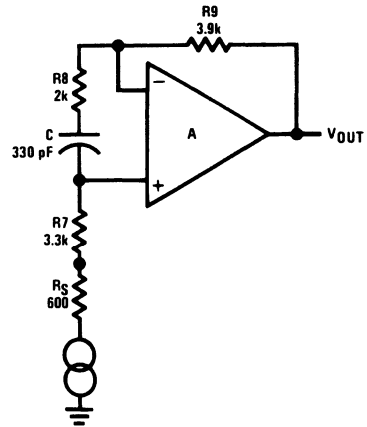
Another application of this technique is for making a fast follower with a high slew rate. An LF356 is specified as a follower, but an LF357 must be applied at an " $A_v = 5$ " minimum, because it has been "decompensated" with a smaller internal capacitor. Most people do not realize how easy it is to apply an LF357 as a follower. In *Figure 4*, an LF357 will have fast, stable response just like an LF356 does, when $R_S < 1 \text{ k}\Omega$, but it will have a $50\text{V}/\mu\text{s}$ slew rate (typical) vs. $12\text{V}/\mu\text{s}$ for an LF356.



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FIGURE 4. Unity-Gain Follower With Fast Slew Rate

Similarly, an LM348 is a fast decompensated quad op amp. Its bipolar input stage has a finite bias current, 200 nA max. For best results, the resistance which makes up the noise gain should be put equally in the **plus** and **minus** input circuits, as shown in *Figure 5*. The LM349 can slew at $2\text{V}/\mu\text{s}$ typical, and is much faster for handling audio signals without distortion than the LM348 (which at $0.5\text{V}/\mu\text{s}$ is only as fast as an ordinary LM741). The same approach can be used for an LM101 with a 5 pF damping capacitor. While these circuits give faster slewing, the bandwidth may degrade if the source impedance R_S increases. Also, when the AC noise gain is raised, the AC noise will also be increased. While most modern op amps have low noise, a noise gain of 10 may make a significant increase in output noise, which the user should check to insure it is not objectionable.



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FIGURE 5. Application of Fast Follower With Balanced Resistors, $R_9 = R_7 + R_S$, A = 1/4 LM349 (or LM101 with 5 pF Capacitor)

If the series capacitor is much larger than necessary, noise will be increased more than necessary. In general, choose the C_5 for *Figure 3*, (e.g.) per these guidelines: (where f_v = unity-gain bandwidth of op amp)

$$C_5 \text{ Min} = \frac{4 \cdot \left(1 + \frac{R_4}{R_5}\right)}{2\pi R_5 \cdot f_v} = \frac{R_4 + R_5}{\frac{\pi}{2} \cdot f_v \cdot (R_5)^2}$$

For best results, choose the design center value of C_5 to be 2 or 3 times $C_5 \text{ min}$.

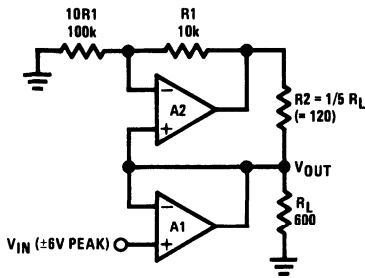
Get More Power Out of Dual or Quad Op-Amps

National Semiconductor
Linear Brief 44
Bob Pease



Although simple brute-force paralleling of op-amps is a bad scheme for driving heavy loads, here is a good scheme for dual op-amps. It is fairly efficient, and will not overheat if the load is disconnected. It is *not* useful for driving active loads or nonlinear loads, however.

In *Figure 1*, an LF353N mini-DIP can drive a 600Ω load to ±9V typical (±6V min guaranteed) and will have only a 47°C temperature rise above free air. If the load R is removed, the chip temperature will rise to +50°C above free air. Note that A2's task is to drive half of the load. A1 could



TL/H/8493-1

A1, A2 = 1/2 LM747 or 1/2 LF353 or any op-amp.

FIGURE 1. A1 and A2 Share the Load

be applied as a unity-gain follower *or* inverter, or as a high-gain or low-gain amplifier, integrator, etc.

While *Figure 1* is suitable for sharing a load between 2 amplifiers, it is not suitable for 4 or more amplifiers, because the circuit would tend to go out of control and overheat if the load is disconnected.

Instead, *Figure 2* is generally recommended, as it is capable of driving large output currents into resistive, reactive, nonlinear, passive, or active loads. It is easily expandable to use as many as 2 or 4 or 8 or 20 or more op-amps, for driving heavier loads.

It operates, of course, on the principle that every op-amp has to put out the same current as A1, whether that current is plus, minus, or zero. Thus if the load is removed, all amplifiers will be unloaded together. A quad op-amp can drive 600Ω to ±11 or 12 volts. Two quads can put out ±40 mA, but they get only a little warm. A series R-C damper of 15Ω in series with 0.047 μF is useful to prevent oscillations (although LM324's do not seem to need any R-C damper).

Of course, there is no requirement for the main amplifier to run only as a unity-gain amplifier. In the example shown in *Figure 3*, A1 amplifies a signal with a gain of +10. A2 helps it drive the load. Then A3 operates as a unity-gain inverter to provide $V_2 = -V_1$, and A4 helps it drive the load. This circuit can drive a floating 2000Ω load to ±20V, accurately, using a slow LM324 or a quick LF347.

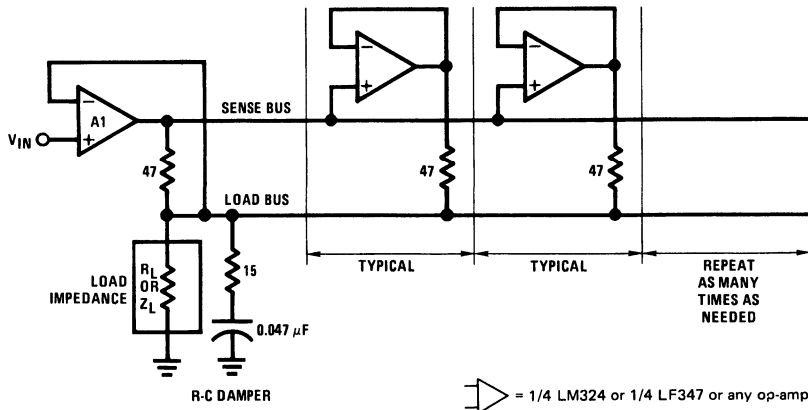


FIGURE 2. Improved Load-Sharing Circuit

TL/H/8493-2

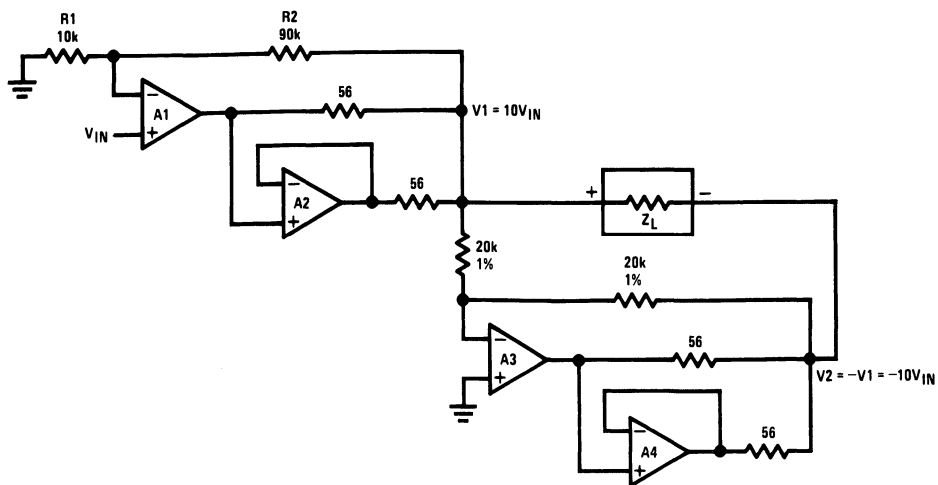


FIGURE 3. Typical Application of Load-Sharing

TL/H/8493-3

Frequency-to-Voltage Converter uses Sample-and-Hold to Improve Response and Ripple

National Semiconductor
 Linear Brief 45
 Fran Terry



Most frequency-to-voltage (F-to-V) converters suffer from the classical tradeoff of ripple versus speed of response. For example, the basic F-to-V converter shown below has 13 mVp-p of ripple, and a rather slow 0.6 second settling time, when C_{FILTER} is 1 μF . If you want less ripple than that, the response time will be even slower. If you want quicker response, it is easy to decrease C_{FILTER} , but the ripple will increase by the same factor.

such as LF398 can sample the F-to-V's output at the peak of its ripple, and hold it until the next cycle. The LF398 has fairly low output ripple (rms) but it does have some short duration noise spikes and glitches which can be removed easily with a simple output filter. The ripple at the output of the active filter V6 is smaller than 1 mV peak, but the settling time for a step change of input frequency is only 60 ms, or ten times quicker than the "basic" FVC with $C_{FILTER} = 1 \mu F$.

The improved circuit in Figure 2 makes an end-run around these compromises. A low-cost sample-and-hold circuit

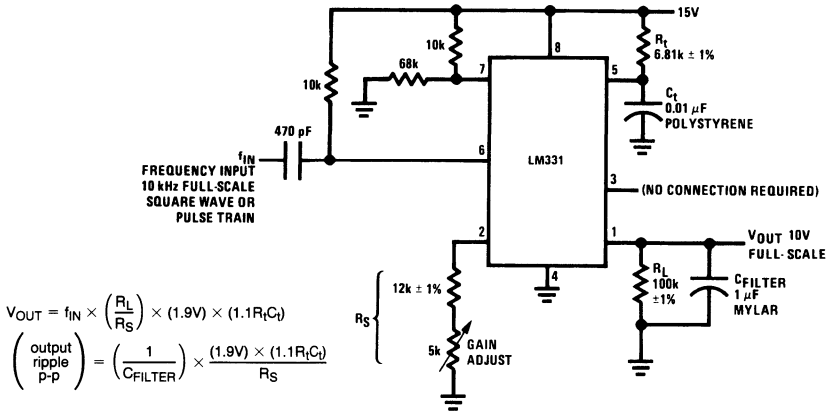


FIGURE 1. Basic Frequency-to-Voltage Converter

TL/H/8494-1

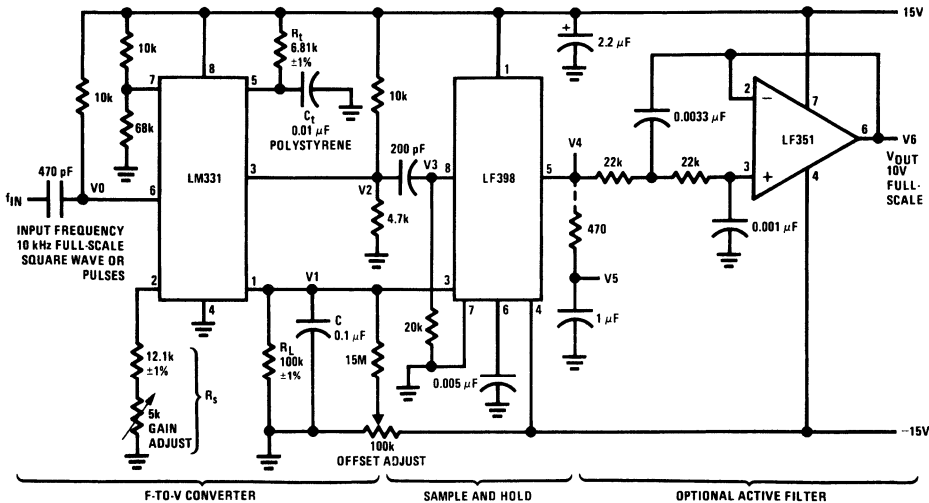


FIGURE 2. Improved F-to-V Converter Using Sample-and-Hold

TL/H/8494-2

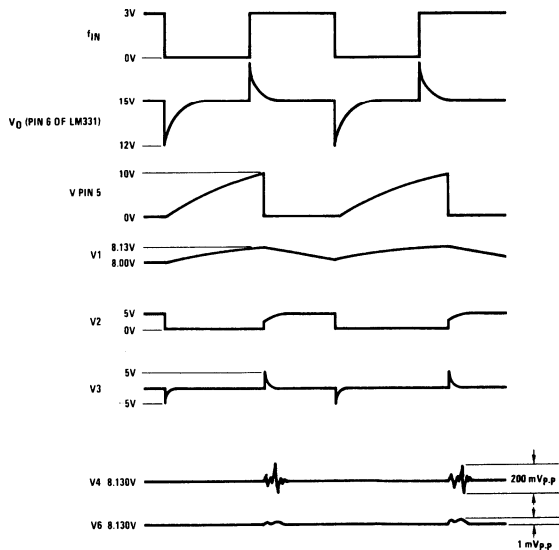
DETAILS OF OPERATION (Refer to *Figure 3, Waveforms*)

When the input frequency waveform has a negative-going transition, pin 6 of the LM331 is driven momentarily lower than the 13V threshold voltage at pin 7. This initiates a timing cycle controlled by the R_t and C_t at pin 5, and also causes a transition from +5V to 0V at pin 3, (the normal VFC logic output) which is usually left unused in F-to-V operation.

During the timing cycle ($t = 1.1 \times R_t \times C_t = 75 \mu s$, for the example shown) a precision current source $i = 1.9 V/R_S$ flows out of pin 1 of the LM331, and charges V1 up to a value slightly higher than the average DC value of V1. At the end of the timing cycle, V1 stops charging up, and also V2 rises. The 10 k Ω pull-up resistor is coupled (through the 200 pF capacitor) to V3, and causes the LF398 to *sample* for about 5 μs . Then the LF398 goes back into *hold*. This entire operation is repeated at the same frequency as f_{IN} . The average voltage at V1 will be the same 10V full scale, according to the same formula of *Figure 1*. And the peak-to-peak ripple can be computed as 65 mV peak, 130 mVp-p, using the appropriate formula.

Now, the input to the sample-and-hold at pin 3 may have a 10.000V average DC value, but the output will be at 10.065V, because the sample occurs at the peak value of V1. Thus, to get an output with low offset, a 15 M Ω resistor is used to offset the V1 signal to a lower level. Trim the offset adjust pot to get $V_{OUT} = 1V$ at 1 kHz, and trim the gain adjust pot to get $V_{OUT} = 10V$ at 10 kHz (the interaction is minor), as measured at V4, V5, or V6. The rms value of the ripple at V4 is rather small, but the peak-to-peak ripple (spikes and glitches) may be excessive. A simple R-C filter can provide a filtered output at V5; or a simple active filter using an inexpensive LF351, will give sub-millivolt (peak) ripple at V6, with improved settling time and low output impedance.

This F-to-V converter will have a good linearity, better than 0.1%, but only from 10 kHz down to 500 Hz. Between 200 Hz and 20 Hz, V_{OUT} is not very proportional to f_{IN} . And at 0 Hz, the output will be indeterminate, because the sample-and-hold will never sample! However, there are many F-to-V applications where a 20:1 frequency range is adequate.



TL/H/8494-3

FIGURE 3. Waveforms, Improved F-to-V Converter

A New Production Technique for Trimming Voltage Regulators

National Semiconductor
Linear Brief 46
Robert A. Pease



Three-terminal adjustable voltage regulators such as the LM317 and LM337 are becoming popular for making regulated supplies in instruments and various other OEM applications. Because the regulated output voltage is easily programmed by two resistors, the designer can choose any voltage in a wide range such as 1.2V to 37V. In a typical example (Figure 1) the output voltage will be:

$$V_{OUT} = V_{REF} \left(\frac{R_2}{R_1} + 1 \right) + R_2 \cdot I_{ADJ}$$

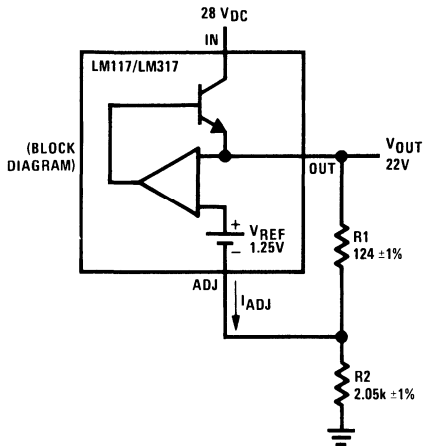


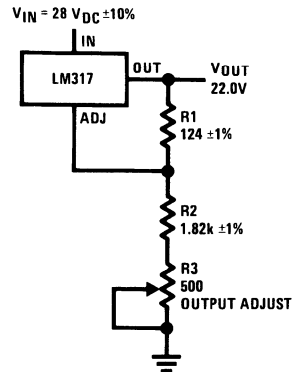
FIGURE 1. Basic Regulator

In many applications, when R1 and R2 are inexpensive $\pm 1\%$ film resistors, and the room temperature accuracy of the LM117 is better than $\pm 3\%$, the overall accuracy of $\pm 5\%$ will be acceptable. In other cases, a tighter tolerance such as $\pm 1\%$ is required. Then a standard technique is to make up part of R2 with a small trim pot, as in Figure 2. The effective range of R2 is $2.07k \pm 10\%$, which is adequate to bring V_{OUT} to exactly 22.0V. (Note that a 200 Ω rheostat in series with 1.96 k $\Omega \pm 1\%$ would not necessarily give a $\pm 5\%$ trim range, because the end resistance and wiper resistance could be as high as 10 Ω or 20 Ω ; and the maximum value of an inexpensive 10% or 20% tolerance trimmer might be as low as 180 Ω or 160 Ω .)

In some designs, the engineering policy may frown on the use of such trim pots, for one or more of the following reasons:

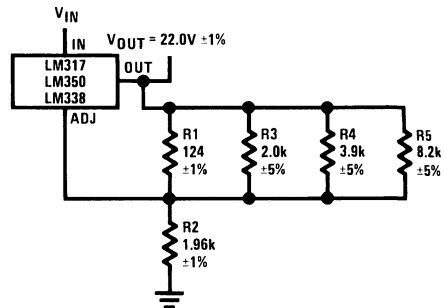
- Good trim pots are more expensive.
- Inexpensive trim pots may be drift or unreliable.
- Any trim pot which can be adjusted can be misadjusted, sooner or later.

To get a tighter accuracy on a regulated supply, while avoiding these disadvantages of trim pots, consider the scheme in Figure 3.



TL/H/8495-2

FIGURE 2. Regulator with Small Adjustment Range



TL/H/8495-3

FIGURE 3. Regulator with Trimmable Output Voltage

When first tested, V_{OUT} will tend to be 4% to 6% higher than the 22.0V target. Then, while monitoring V_{OUT} , snip out R3, R4, and/or R5 as appropriate to bring V_{OUT} closer to 22.0V. This procedure will bring the tolerance inside $\pm 1\%$:

- If V_{OUT} is 23.08V or higher, cut out R3 (if lower, don't cut it out).
- Then if V_{OUT} is 22.47V or higher, cut out R4 (if lower, don't).
- Then if V_{OUT} is 22.16V or higher, cut out R5 (if lower, don't).

The entire production distribution will be brought inside $22.0V \pm 1\%$, with a cost of 3 inexpensive carbon resistors, much lower than the cost of any pot. After the circuit is properly trimmed, it is relatively immune to being misadjusted by a screwdriver. Of course, the resistors' carcasses must be properly removed and disposed of, for full reliability to be maintained.

An alternate scheme shown in Figure 4 has R6, R7, and R8 all shorted out initially with a stitch or jumper of wire. The

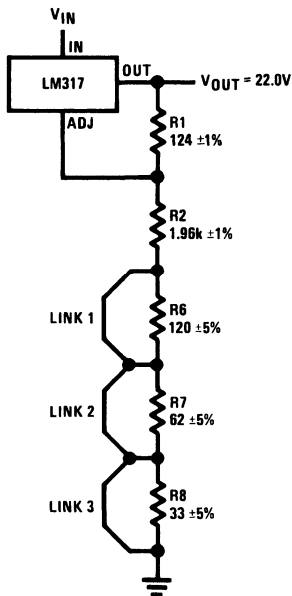
trim procedure is to open up a link to bring a resistor into effect. The advantage of this circuit is that V_{OUT} starts out lower than the target value, and never exceeds that voltage during trimming. In this scheme, note that a total "pot resistance" of 215Ω is plenty for a 10% trim span, because the *minimum* resistance is always below 1Ω , and the maximum resistance is always more than 200Ω —it can cover a much wider range than a 200Ω pot.

The circuit of Figure 5 shows a combination of these trims which provides a new advantage, if a $\pm 2\%$ max tolerance is adequate. You may snip out R4, or link L1, or both, to accommodate the worst case tolerance, but in most cases, the output will be within spec without doing any trim work at

all. This takes advantage of the fact that most $\pm 1\%$ resistors are well within $\pm 1/3\%$, and most LM337's output voltage tolerances are between $-1/2\%$ and $+1 1/2\%$, to cut the average trim labor to a minimum. Note that L1 could be made up of a $2.7\Omega \pm 10\%$ resistor which may be easier to handle than a piece of wire.

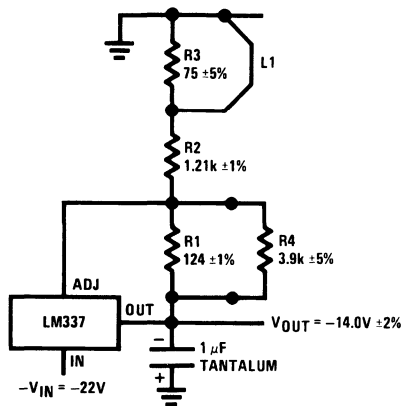
In theory, a 10% total tolerance can be reduced by a factor of $(2^n - 1)$ when n binary-weighted trims are used. In practice, the factor would be $(1.8^n - 1)$ if $\pm 10\%$ trim resistors are used, or $(1.9^n - 1)$ if $\pm 5\%$ resistors are used. For $n = 2$, a 10% tolerance can be cut to 3.8% p-p or $\pm 1.9\%$. For $n = 3$, the spread will be 1.7% p-p or $\pm 0.85\%$, and most units will be inside $\pm 0.5\%$, perfectly adequate for many regulator applications.

National Semiconductor manufactures several families of adjustable regulators including LM117, LM150, LM138, LM117HV, LM137, and LM137HV, with output capabilities from 0.5A to 5A and from 1.2V to 57V. For complete specifications and characteristics, refer to the appropriate data sheet or the 1982 Linear Databook.



If V_{OUT} is lower than 20.90V, snip link 1 (if not, don't).
 Then if V_{OUT} is lower than 21.55V, snip link 2 (if not, don't).
 Then if V_{OUT} is lower than 21.82V, snip link 3 (if not, don't).

FIGURE 4. Alternate Trim Scheme



If $|V_{OUT}|$ is smaller than 13.75V, snip L1 and it will get bigger by 6%.
 Then if $|V_{OUT}|$ is bigger than 14.20V, snip R4 and it will get smaller by 3%.

FIGURE 5. Circuit Which Usually Needs No Trim to Get V_{OUT} Within $\pm 2\%$ Tolerance

TL/H/8495-4

TL/H/8495-5

High Voltage Adjustable Power Supplies

National Semiconductor
Linear Brief 47
Michael Maida



7.4.4 HIGH VOLTAGE ADJUSTABLE POWER SUPPLIES

The floating-mode operation of adjustable three-terminal regulators such as the LM117 family make them ideal for high voltage operation. The regulator has no ground pin; instead, all the quiescent current (about 5 mA) flows to the output terminal. Since the regulator sees only the input-output differential, its voltage rating — 40V for the standard LM117 series and 60V for the high voltage LM117HV series — will not be exceeded for outputs of hundreds of volts. However, the IC may break down when the output is shorted unless special design approaches are used to protect against it.

Figure 1 shows how it's done. Zener diode D1 ensures that the LM317H sees only a 5V input-output differential over the entire range of output voltage from 1.2V to 160V. Since

high-voltage transistors by necessity have a low β , a Darlington is used to stand off the high voltage. The zener impedance is low enough that no bypass capacitor is required directly at the LM317 input. (In fact, *no* capacitor should be used here if the circuit is to survive an output short!) R3 limits short circuit current to 50 mA. The RC network on the output improves transient response as does bypassing the ADJUST pin, while R4 and D2 protect the ADJUST pin during shorts.

Since Q2 may dissipate up to 5W normally or 10W during a short circuit, it should be well heat sunk. For higher output currents substitute a pass device in a TO-3 or TO-220 package in place of the TO-202 NSD134 and reduce R3. Of course, if the required output current is less than 25 mA, R3 can be increased to reduce the size of the heat sink needed.

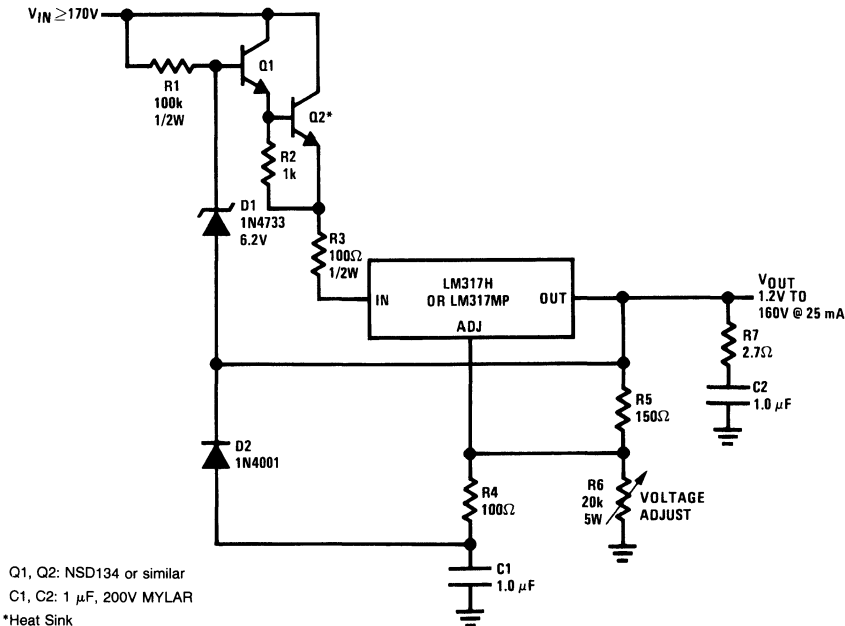


FIGURE 1. Basic High Voltage Regulator

TL/H/7335-1

An improved approach is shown in *Figure 2*. Here an LM329B 6.9V zener reference has been stacked in series with the LM317's internal reference. This both improves temperature stability, since the LM329B has a guaranteed TC of ± 20 ppm/ $^{\circ}\text{C}$, and improves regulation, because more loop gain is available from the LM317.

These techniques can be extended for higher output voltages and/or currents by either using better high voltage transistors or cascoding or paralleling (with appropriate emitter ballasting resistors) several transistors. The output short circuit current, determined by R3, must be within Q2's safe area of operation so that secondary breakdown cannot occur.

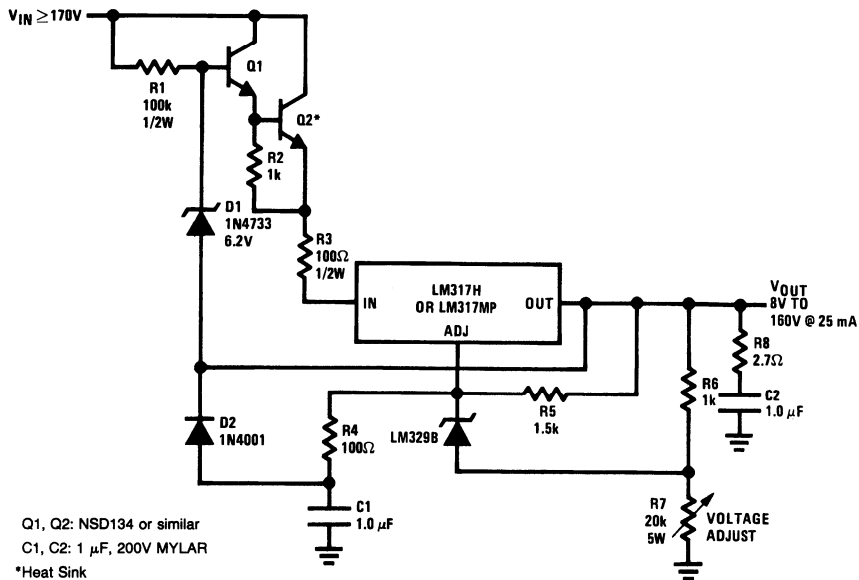


FIGURE 2. Precision High Voltage Regulator

TL/H/7335-2

Simple Voltmeter Monitors TTL Supplies

National Semiconductor
Linear Brief 48
Michael Maida



Using a National Semiconductor LM3914 bar/dot display driver chip, a few resistors and some LEDs, a simple expanded-scale voltmeter is easily constructed. Furthermore, it runs from the same single $5V \pm 10\%$ supply it monitors and can provide TTL-compatible undervoltage and overvoltage warning signals.

The complete circuit is shown in *Figure 1*. Resistors R1 and R2 attenuate V_{CC} by a factor of three at the LM3914 signal input, ensuring proper biasing of the IC with V_{CC} as low as 4V. The IC's internal reference sets the voltage across the series combination of R3, R4 and R5 at 1.25V, establishing a reference load current of about 1 mA. This current is joined by the small, constant current from the reference adjust pin ($75 \mu A$, typ) and flows to ground through R6 and R7, developing a voltage drop. Adjusting R6 varies this voltage drop and, consequently, the voltage at pin 7, nominally $1.803V (= 5.41V/3)$.

Pin 7 is connected to the top of the LM3914's internal ten-step voltage divider (pin 6). The bottom of this divider (pin 4) is connected to the center tap of potentiometer R4. By varying the pot setting this voltage can be set to 1.47V ($= 4.41V/3$) without significantly affecting the potential at

pin 7. The optional diode D1 protects against damaging the IC by connecting the leads backwards.

In operation, the LM3914's ten internal voltage comparators compare the signal input, $V_{CC}/3$, to the reference voltage on the divider, lighting each successive LED for every 100 mV increase in V_{CC} above 4.5V as shown. The LM3914 regulates the LED currents at 10 times the reference load current, here about 10 mA, so external current-limiting resistors are not required. With pin 9 left open circuit, the LM3914 functions in Dot mode (only one LED on at a time). If desired, a Bar mode display could be obtained by connecting pin 9 to V_{CC} , but the dot display seems more suitable in this application.

To calibrate, set V_{CC} at 5.41V and adjust R6 until LED #9 and LED #10 are equally illuminated. (A built-in overlap of about 1 mV ensures all LEDs won't go out at a threshold point.) There's no need to vary the system supply voltage to perform this adjustment. Instead, disconnect R1 from V_{CC} and connect it to an accurate reference. Then, at 4.5V, adjust R4 until LED #1 just barely turns on. There is a slight interaction caused by the finite resistance (10k, typ) of the LM3914's voltage divider, so that repeating the above procedure once is advised.

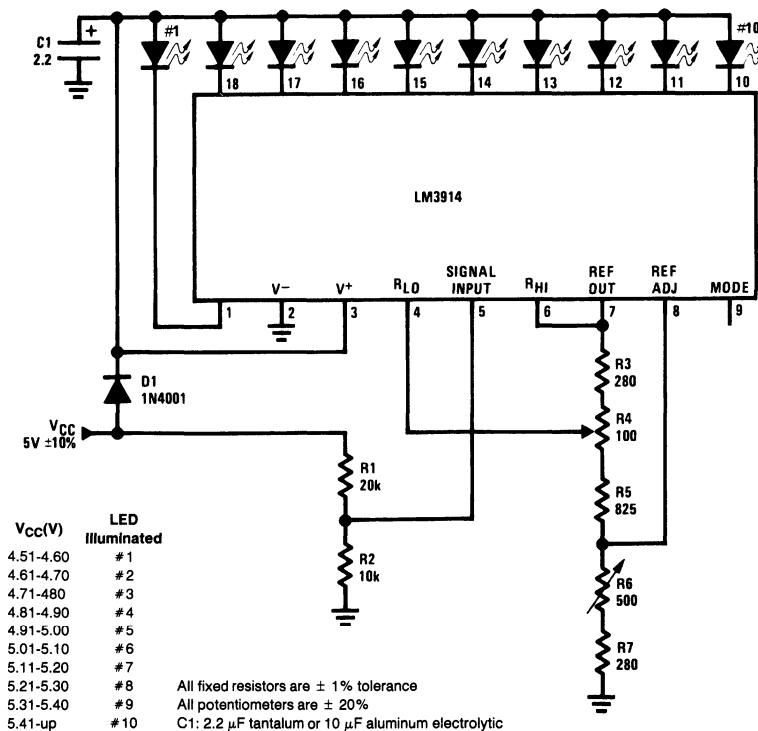


FIGURE 1. 5V Power Supply Monitor

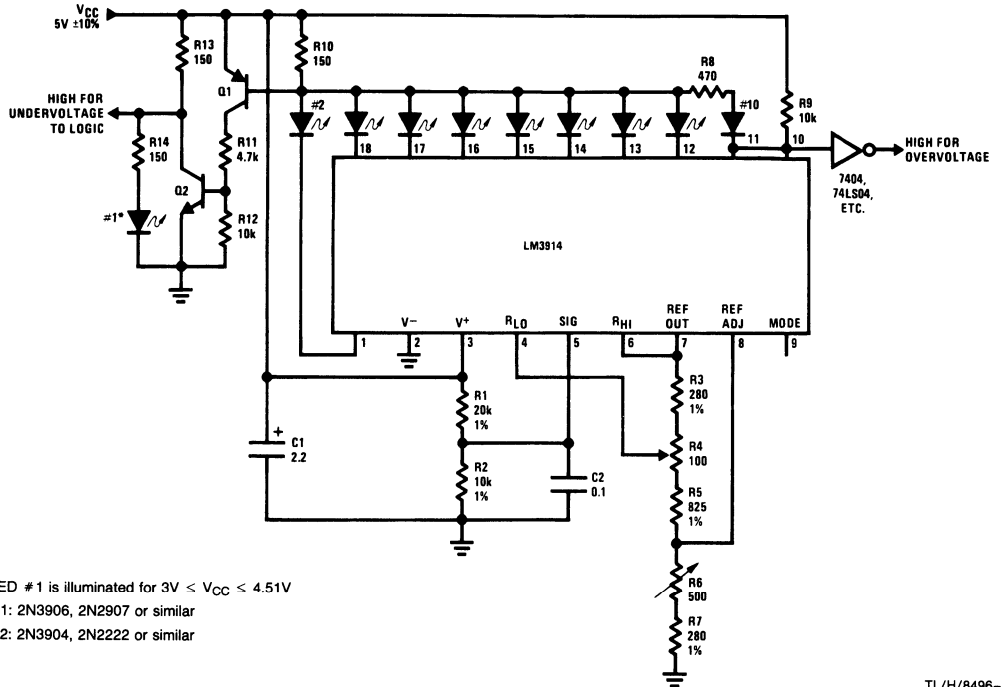
TL/H/8496-1

The LED driver outputs can directly drive a TTL gate, so that the LED #1 and LED #10 outputs may be used for undervoltage and overvoltage warning signals. These may be used to initiate a soft shutdown or summon an operator, for example. The interfacing circuitry is shown in *Figure 2*. The 470Ω resistor R8 ensures that the LM3914 output will saturate to provide the proper TTL low level. Pull-up resistor R9 provides the logic high level.

In the previous circuit the undervoltage LED goes out when V_{CC} is less than 4.51V, a deficiency that is corrected here, Transistors Q1 and Q2 shut off LED #1 whenever any other LED is turned on by the LM3914. Q2's output will directly drive TTL.

Calibration procedure is the same as before. The LM3914 output thresholds have been shifted up by 100 mV and output #10 is or-tied with output #9. Other outputs may be wire-or'd together if 100 mV resolution is not necessary. If desired, the outputs can be color coded by making LED #1 and LED #10 red, LED #2 and LED #9 amber, and the rest of the LEDs green to ease interpretation.

This circuit is useful where quick and easy voltage adjustments must be made, such as in the field or on the production line. The circuit's low cost makes it feasible to incorporate it into the system, where the overvoltage and undervoltage warning signals provide an attractive extra. Of course, these techniques can be used to monitor any higher voltages, positive or negative.



*LED #1 is illuminated for $3V < V_{CC} < 4.51V$
 Q1: 2N3906, 2N2907 or similar
 Q2: 2N3904, 2N2222 or similar

FIGURE 2. Power Supply Monitor with TTL Interface and Extended Undervoltage Range

TL/H/8496-2

Programmable Power Regulators Help Check Out Computer System Operating Margins

National Semiconductor
Linear Brief 49
Robert Pease



It is a familiar situation that some computer systems which are functional with a 5V supply may run marginally at 5.1V but can show a solid failure at 5.3V (or, vice versa) even though all these voltages are within the system's specifications. The LM338 is an example of a monolithic voltage regulator which can be placed under computer control, and can trim the supply to a particular variation above (and below) the design-center voltage. Simultaneously the computer is exercised through a standard test sequence. Any deviation from correct functioning, at one supply voltage level or another, will serve as a warning of impending malfunction or failure. This test approach can be used for diagnostics, for troubleshooting, and for engineering evaluation. It can help detect skew, race conditions, timing problems, and noise and threshold problems.

HERE'S HOW

During normal operation, the latch (IC 1) is programmed to have its Q1 and Q2 outputs *HIGH*, and its Q3 and Q4 *LOW*. Then R4 and R5 are connected effectively in parallel with R6, and V_{OUT} is adjusted to 5V. If Q4 is commanded *HIGH*, the net conductance from the *adjust bus* to ground will decrease, and V_{OUT} will rise 3% to 5.151V. Conversely if Q1 is commanded *LOW*, the output voltage will fall 3.3% to 4.835V. The complete list of output voltages (in approximately 3.2% steps) is shown in Table I, covering a $\pm 9.5\%$ total range.

The same basic function can be accomplished for $-5.2V$ regulators (as are used for ECL) using LM337 negative adjustable regulators. If the command is from TTL latches, the circuit of *Figure 2* will be suitable to interface between the (0V and 2.4V) logic levels and the saturated PNP collectors

as shown. The resistors R101–R104 are switched by transistors Q101–Q104 in a similar way to *Figure 1*. Note that the resistors in *Figure 2* are in a binary-weighted proportion. To decrease V_{OUT} by 2%, just change Q4 to *LOW*; but to increase V_{OUT} by 2%, set Q1 *HIGH* and Q2, Q3, Q4 all *LOW*, in a standard offset binary scheme.

TABLE I. Available Trim Range

Q1	Q2	Q3	Q4	V_{OUT}	$\% \Delta V_{OUT}$
1	1	0	0	5.000V	(trimmed)
1	1	0	1	5.151V	+3.0%
1	1	1	0	5.299V	+6.0%
1	1	1	1	5.469V	+9.4%
0	1	0	0	4.835V	-3.3%
1	0	0	0	4.669V	-6.6%
0	0	0	0	4.526V	-9.5%

Figure 2 also provides another feature. If Q5 goes *LOW*, Q105 will saturate and pull the *adjust bus* to within 100 mV of ground, and the V_{OUT} will collapse to $-135V$. The negative supply will be effectively shut down, and the computer will draw substantially zero power.

In an extreme case of automation, the computer could trim the $-5.2V$ supply to the "best" value, and the trimpot would be completely superfluous. The circuit of *Figure 2* has a trim resolution of 3% steps, and can set V_{OUT} well within 2% of the ideal value, so long as some measurement has decided which voltage is "ideal".

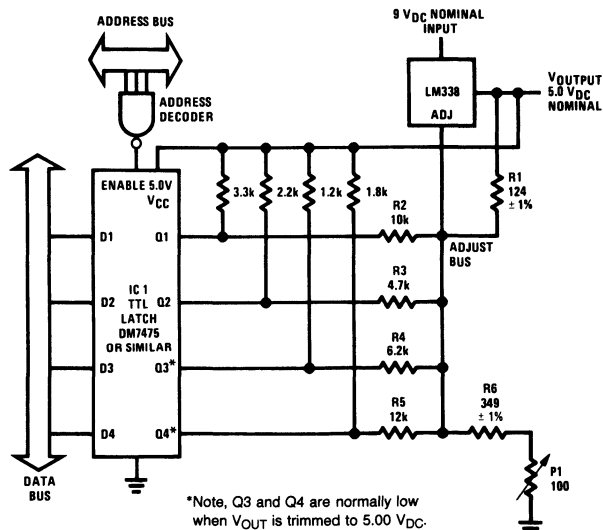


FIGURE 1. Programmable Power Supply

TL/H/7336-1

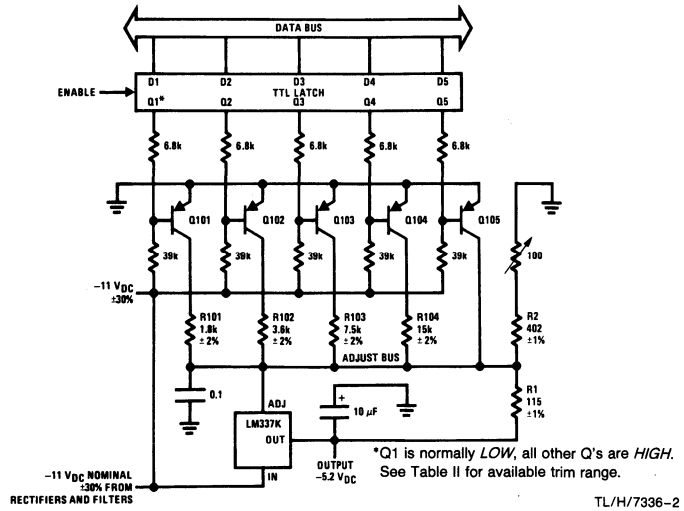


FIGURE 2. Programmable Negative Supply

TABLE II. Available Trim Range

Q1	Q2	Q3	Q4	V _{OUT}	%ΔV _{OUT}
0	1	1	1	5.200V	(trimmed)
0	1	1	0	5.110V	-1.7%
0	1	0	1	5.025V	-3.4%
0	1	0	0	4.944V	-4.9%
0	0	1	1	4.853V	-6.7%
0	0	1	0	4.779V	-8.1%
0	0	0	1	4.707V	-9.5%
0	0	0	0	4.638V	-10.8%
1	0	0	0	5.310V	+2.1%
1	0	0	1	5.409V	+4.0%
1	0	1	0	5.513V	+6.0%
1	0	1	1	5.622V	+8.1%
1	1	0	0	5.757V	+10.7%
1	1	0	1	5.880V	+13.1%
1	1	1	0	6.010V	+15.6%
1	1	1	1	6.147V	+18.2%

Figure 2 combines Kelvin sensing with paralleling, where the voltage loss across the current sharing resistors is corrected by the sensing connection. r_{s1} through r_{s3} are equal lengths of #22 gauge lead wire which act as ballasting resistors. These resistors can be kept small because LM338 adjustment pins are paralleled, forcing the outputs to track to within about 60 mV. r_{s4} consists of the parasitic resistance of any additional output lead plus connector loss. The

total loss for r_{s4} may be up to 0.25V without loss of proper Kelvin sensing. Note that if U1 has the lowest reference voltage of the three regulators, full Kelvin sensing might not become effective until output current has increased above a threshold value of several amps. If this is undesirable, the adjustment pin of U1 may be connected to a 5Ω tap on R1, increasing its effective reference voltage by 50 mV. The current load for U1 would be 1.5 amps higher, however.

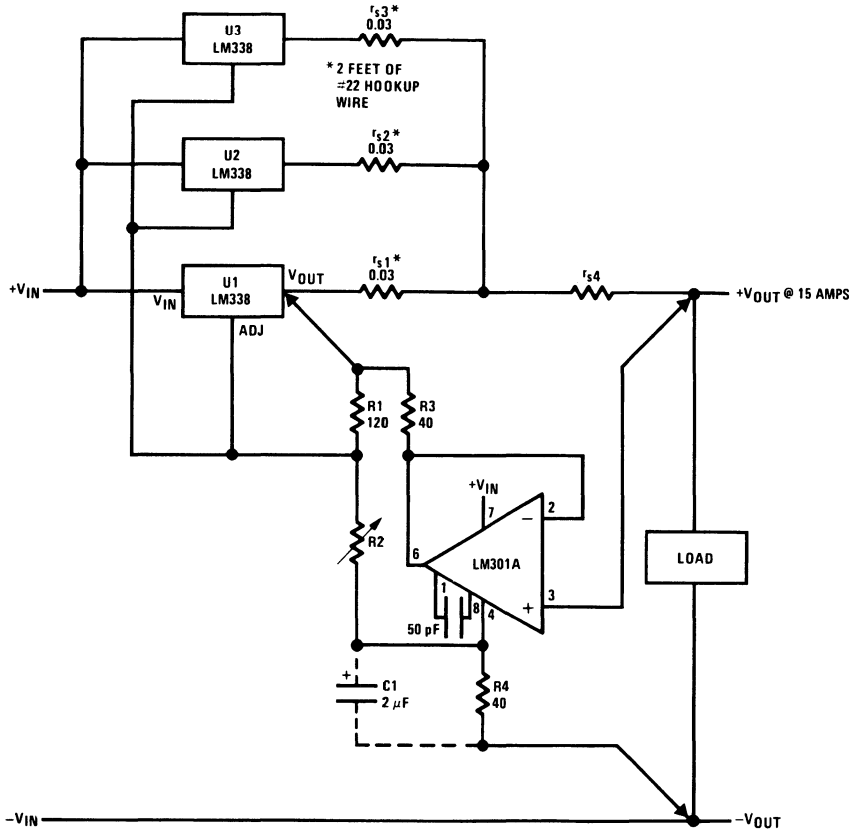


FIGURE 2

TL/H/8498-2

A Low-Noise Precision Op Amp

National Semiconductor
Linear Brief 52
Robert A. Pease



It is well known that the voltage noise of an operational amplifier can be decreased by increasing the emitter current of the input stage. The signal-to-noise ratio will be improved by the increase of bias, until the base current noise begins to dominate. The optimum is found at:

$$I_{e(\text{optimum})} = \frac{KT}{q} \frac{\sqrt{h_{FE}}}{r_s}$$

where r_s is the output resistance of the signal source. For example, in the circuit of *Figure 1*, when $r_s = 1 \text{ k}\Omega$ and $h_{FE} = 500$, the I_e optimum is about $500 \mu\text{A}$ or $560 \mu\text{A}$. However, at this rich current level, the DC base current will cause a significant voltage error in the base resistance, and even after cancellation, the DC drift will be significantly bigger than when I_e is smaller. In this example, $I_b = 1 \mu\text{A}$, so $I_b \times r_s = 1 \text{ mV}$. Even if the I_b and r_s are well matched at each input, it is not reasonable to expect the $I_b \times r_s$ to track better than 5 or $10 \mu\text{V}/^\circ\text{C}$ versus temperature.

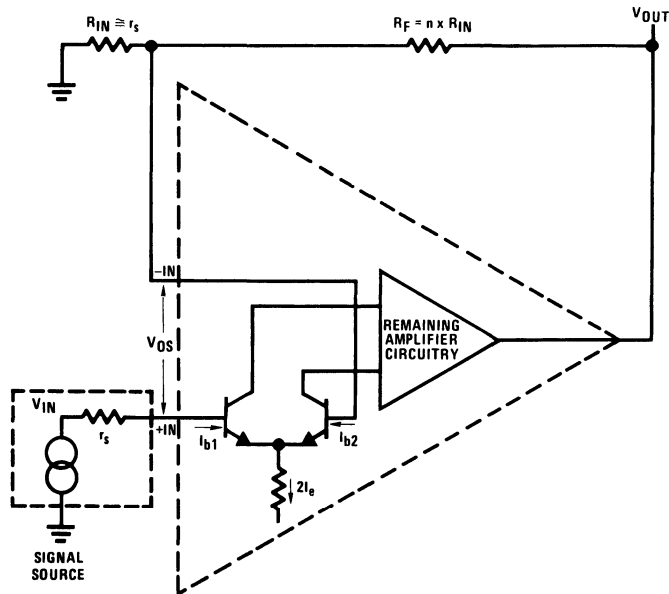
A new amplifier, shown in *Figure 2*, operates one transistor pair at a rich current, for low noise, and a second pair at a much leaner current, for low base current. Although this looks like the familiar Darlington connection, capacitors are added so that the noise will be very low, and the DC drift is very good, too. In the example of *Figure 2*, Q2 runs at $I_e = 500 \mu\text{A}$ and has very low noise. Each half of Q1 is operated at $11 \mu\text{A} = I_b$. It will have a low base current (20 nA to 40 nA typical), and the offset current of the com-

posite op amp, $I_{b1} - I_{b2}$, will be very small, 1 nA or 2 nA. Thus, errors caused by bias current and offset current drift vs. temperature can be quite small, less than $0.1 \mu\text{V}/^\circ\text{C}$ at $r_s = 1000\Omega$.

The noise of Q1A and Q1B would normally be quite significant, about $6 \text{ nV}/\sqrt{\text{Hz}}$, but the $10 \mu\text{F}$ capacitors completely filter out the noise. At all frequencies above 10 Hz, Q2A and Q2B act as the input transistors, while Q1A and Q1B merely buffer the lowest frequency and DC signals.

For audio frequencies (20 Hz to 20 kHz) the voltage noise of this amplifier is predicted to be $1.4 \text{ nV}/\sqrt{\text{Hz}}$, which is quite small compared to the Johnson noise of the $1 \text{ k}\Omega$ source, $4.0 \text{ nV}/\sqrt{\text{Hz}}$. A noise figure of 0.7 dB is thus predicted, and has been measured and confirmed. Note that for best DC balance $R_6 = 976\Omega$ is added into the feedback path, so that the total impedance seen by the op amp at its negative input is $1 \text{ k}\Omega$. But the 976Ω is heavily bypassed, and the total Johnson noise contributed by the feedback network is below $1/2 \text{ nV}/\sqrt{\text{Hz}}$.

To achieve lowest drift, below $0.1 \mu\text{V}/^\circ\text{C}$, R1 and R2 should, of course, be chosen to have good tracking tempco, below 5 ppm/ $^\circ\text{C}$, and so should R3 and R4. When this is done, the drift referred to input will be well below $0.5 \mu\text{V}/^\circ\text{C}$, and this has been confirmed, in the range $+10^\circ\text{C}$ to $+50^\circ\text{C}$. Overall, we have designed a low-noise op amp which can rival the noise of the best audio amplifiers, and at the same



TL/H/8499-1

$$V_{OUT} \approx (n+1)V_{IN} + V_{OS} \times (n+1) + (I_{b2} - I_{b1}) \times r_s \times (n+1) + V_{noise} \times (n+1) + I_{noise} \times (r_s + R_{IN}) \times (n+1)$$

FIGURE 1. Conventional Low-Noise Operational Amplifier

time exhibits drift characteristics of the best low-drift amplifiers. The amplifier has been used as a precision pre-amp (gain = 1000), and also as the output amplifier for a 20-bit DAC, where low drift and low noise are both important.

To optimize the circuit for other r_s levels, the emitter current for Q2 should be proportional to $1/\sqrt{r_s}$. The emitter current of Q1A should be about ten times the base current of Q2A. The base current of the output op amp should be no more than 1/1000 of the emitter current of Q2. The values of R1 and R2 should be the same as R7.

Various formulae for noise:

$$\text{Voltage noise of a transistor, per } \sqrt{\text{Hz}}, e_n = KT \sqrt{\frac{2}{qI_C}}$$

$$\text{Current noise of a transistor, per } \sqrt{\text{Hz}}, i_n = \sqrt{\frac{2qI_C}{h_{FE}}}$$

$$\text{Voltage noise of a resistor, per } \sqrt{\text{Hz}}, e_n = \sqrt{4 KTR_s}$$

For a more complete analysis of low-noise amplifiers, see AN-222, "Super Matched Bipolar Transistor Pair Sets New Standards for Drift and Noise", Carl T. Nelson.

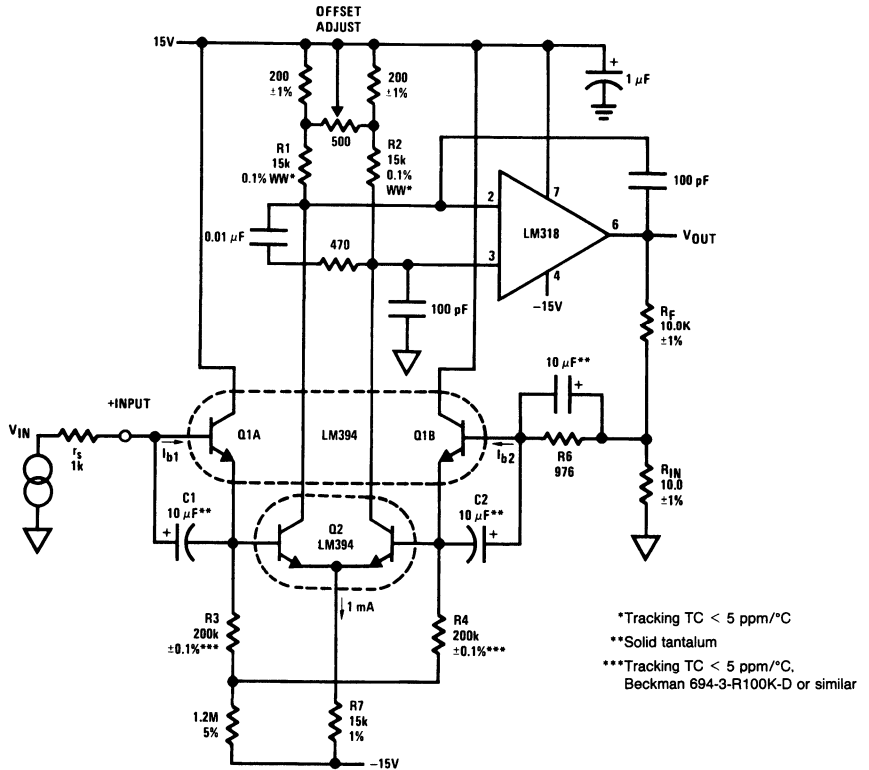


FIGURE 2. New Low-Noise Precision Operational Amplifier as Gain-of-1000 Pre-Amp

TL/H/8499-2

μP Interface for a Free-Running A/D Allows Asynchronous Reads

National Semiconductor
 Linear Brief 53
 Tim Regan



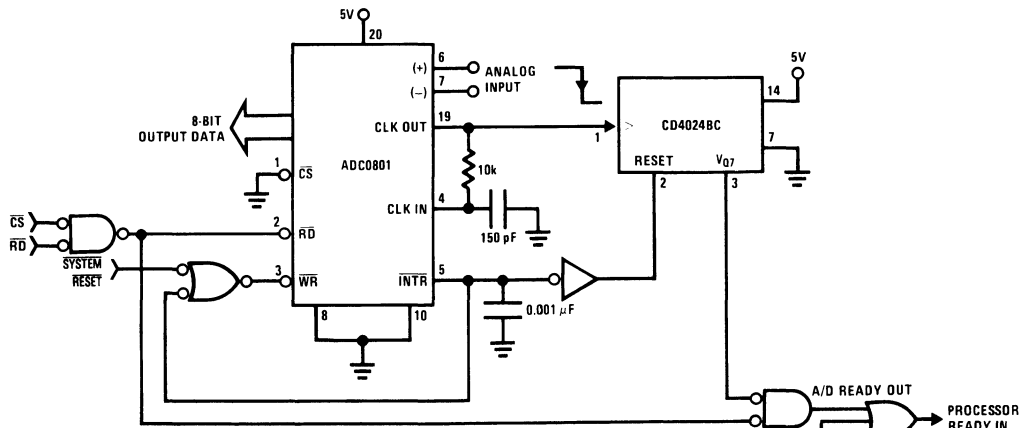
In many data acquisition applications it is necessary to have an A to D converter operate at its maximum conversion rate. The controlling microprocessor would then be able to read the most current input data at any point in time as required by software. To minimize program execution time, a DATA READ may not be synchronous to the completion of a conversion, and herein lies a problem. It is entirely possible that the processor could assert a READ command right at the instant the A/D converter is updating its output register. The data read would be the value of the converter's output lines in transition from the result of the previous conversion to the latest result, and would very likely be in error.

The addition of a simple binary counter to the A/D interface circuitry can be used to generate a READY signal to the microprocessor that will prevent a READ during a data update. The circuit of Figure 1 shows a CD4024BC7-stage ripple carry binary counter used in conjunction with an ADC0801, 8-bit microprocessor compatible A to D converter. First of all, the free-running conversion time of the A/D must be a constant number of clock cycles; and secondly, the output latches must be updated prior to the end of conversion signal. The ADC0801 fulfills both of these requirements. The output data latches are updated one A/D clock period before the INTR falls low, and the free-running conversion time is always 72 clock periods long.

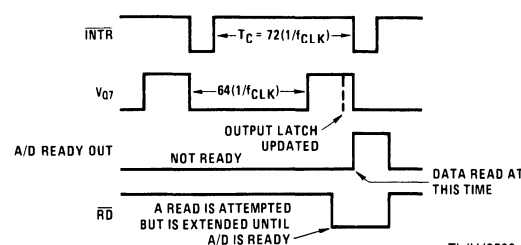
As part of the system power-up initialization sequence, a logic low must be temporarily applied to the SYSTEM RESET input to the A/D to force the converter to start. At the end of a conversion, the INTR output goes low, and both resets the counter outputs to all zeros and signals another conversion to start by pulling WR low. The length of time that the INTR output stays low is normally only a few internal gate propagation delays (approximately 300 ns) and is independent of the A/D clock frequency. The 1000 pF capacitor on this output extends this time to approximately 1 μs to insure adequate reset time for the counter.

A conversion is started on the low to high transition of the INTR and WR pins. The next data update will occur 71 clock periods after this edge occurs. The counter will signal that a data update is about to occur after 64 clock periods. If the processor attempts a DATA READ within an 8 clock period time frame around the data update time, its READY input line will remain low, signifying a NOT READY condition. The processor would then extend the READ cycle time until it receives a READY indication created by the counter being reset by INTR. This insures that the latches have already been updated and proper data will be read.

If a READ is attempted during the 64 clock period interval after the start of a conversion, the READY IN line to the processor will go high to permit a normal READ cycle, and



Timing Diagram



TL/H/8500-2
FIGURE 1

TL/H/8500-1

the data output by the A/D will be the result of the previous conversion. The processor READY IN logic, as shown, requires that all system devices that may need special READ or WRITE timing provide a NOT READY (a Logic 0 on their READY OUT lines) indication until selected to be read from or written to.

The chance of having the processor extend its READ cycle time is 1 in 9 (8 clock periods out of 72) and the maximum length of time a READ would be extended is 8 A/D clock periods. These two timing considerations are insignificant trade-offs to take to insure that proper A/D data is always read.

Circuit for Evaluation of Custom Vocabulary EPROM Prototype Set

National Semiconductor
Linear Brief 54
Fred Wickersham



EPROM PROTOTYPE

In the process of developing a product with a "custom" generated vocabulary, it may be necessary to develop special circuitry for listening to and evaluating your prototype synthesized vocabulary prior to committing to read only memory (ROM) production.

The prototype set will normally be supplied by National Semiconductor in the form of 2716 EPROM (Intel pinout) sets. The SPC (speech processor chip, part number MM54104) communication with EPROM sets *does* require some external hardware considerations which may not be necessary in the final ROM application, especially in multiple EPROM-equivalent ROM situations. (For example, four 16k-bit 2716 EPROMs equal one 64k-bit ROM.)

Shown on next page is a recommended circuit which shows proper interface between 2716 EPROMs and the SPC. The circuit covers vocabularies from the minimum system of one 2716 (16k bits) to larger vocabularies of eight 2716s (128k bits). It is also true, that in an application requiring only one 2716, the MM74LS138 decoder device can be eliminated by connecting pin 20 of the 2716 to V_{SS} (ground). The remaining unused pins 36, 37 and 38 of the SPC can be left unconnected in this case.

UNUSED SPEC INPUTS

In any DIGITALKER™ design, an applications suggestion is in the area of unused input pins of the SPC. It should be understood that the number of different expressions and coincident addresses, as designated by the custom vocabulary, determines how many of the SW word address pins (pins 8–15) on the SPC are utilized. Vocabularies of less than 128 addresses will not use SW 8; vocabularies of less than 64 addresses will not use SW 7 or SW 8, and etc. These unused SW pins must be tied to V_{SS} (ground) to simplify the application. In fact, *any* unused *input* to the SPC must be tied to V_{SS} .

FILTERING

Use of the DIGITALKER is quite straightforward, however, a point on application that must be covered in this brief concerns the frequency response of the output speech. The ultimate quality of the DIGITALKER will strongly depend upon the filter, amplifier and speaker choices made by the

user. For that reason, it is important to understand the output characteristics of the device.

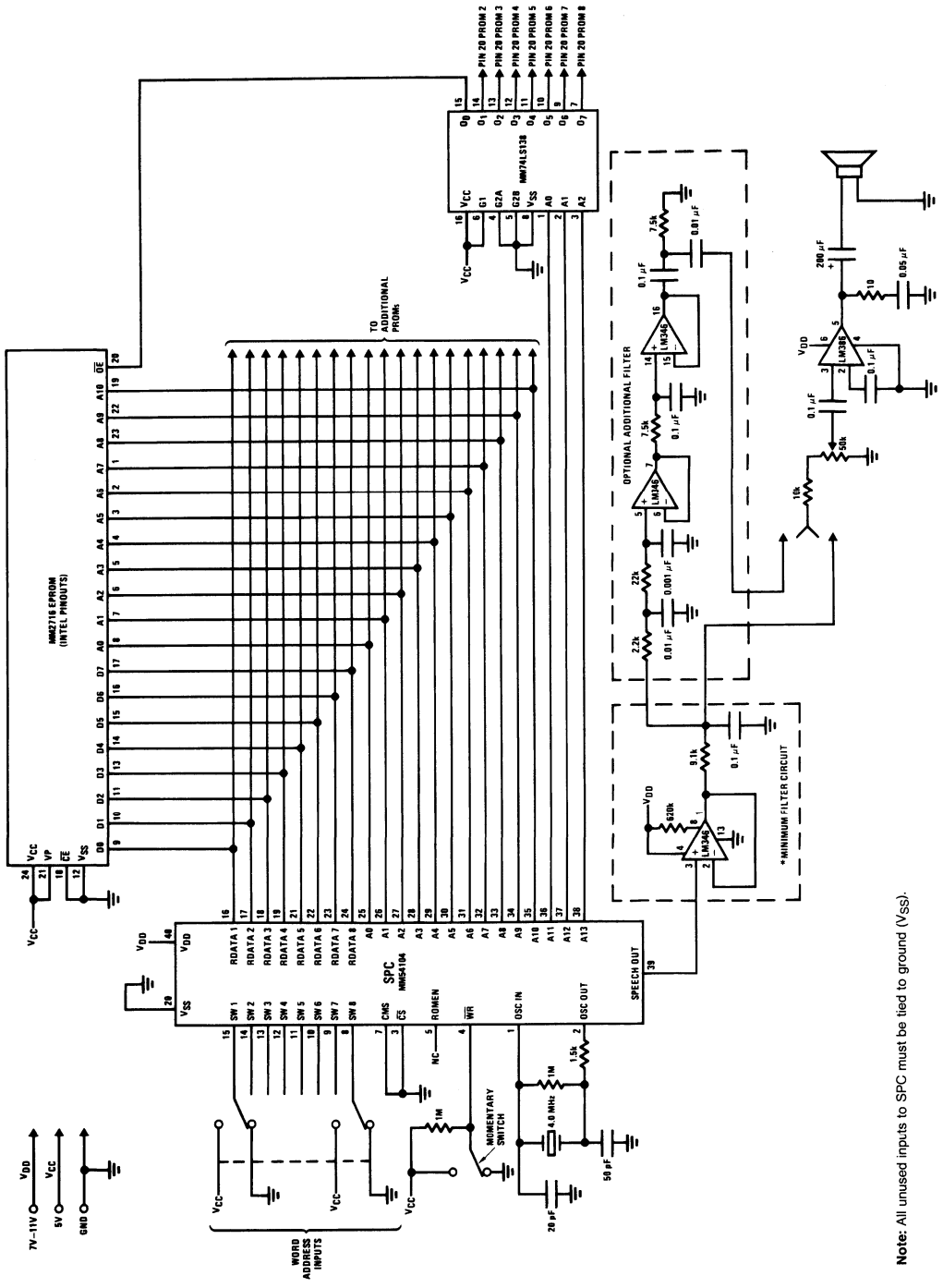
Because the synthesized speech data is derived from a differentiated and sampled input signal, it is necessary to pass the output waveform of the MM54104 through a low-pass filter with a cutoff frequency of approximately 200 Hz and an attenuation characteristic of 20 dB/decade. This compensates for the high frequency pre-emphasis used in the synthesis technique. If the system of interest has a natural roll-off near 200 Hz, this low-pass filter can be eliminated. The important item is that the entire audio system should have a cutoff frequency of approximately 200 Hz. The placement of the cutoff frequency may be adjusted for the particular type of voice being synthesized. A low pitched man's voice might sound better with a 100 Hz cutoff point while women's and children's voices may show improvements with a 300 Hz cutoff.

As an example of how the overall frequency response of a particular application can minimize the need for extra filtering, consider the DIGITALKER as a voice announcement circuit in a telephone system.

In this case, the telephone network provides a natural attenuation to high frequencies that balances the SPC high frequency pre-emphasis. As a result, the low-pass filter previously mentioned can be eliminated. However, because signal frequencies above 3 kHz must be attenuated before they are allowed to pass into the telephone network, a cutoff filter of 3400 Hz may be required in place of the previously mentioned 200 Hz low-pass filter. A good filter for this application is the National Semiconductor AF133 active filter.

In addition to the 200 Hz to 3400 Hz low-pass filter, an extra stage of low-pass filtering can be used for frequencies above 7 kHz. This filter is optional and is normally only used to further reduce sampling noise. Most systems can omit this filter, especially if the overall system bandwidth is not very wide. A second optional filter can be included to limit the overall low frequency response of the system. This high-pass filter would normally cutoff below 200 Hz (adjusted to match the 200 Hz low-pass if provided). This high-pass filter limits low frequency noise, and can usually be omitted if system characteristics do not require this function.

Recommended Circuit for Evaluating up to 8 Custom Encoded EPROMs (2716)



Note: All unused inputs to SPC must be tied to ground (VSS).

*Recommended filter requirements. See text and MM54104 data sheet for complete filter application suggestions.

The Monolithic Operational Amplifier: A Tutorial Study

National Semiconductor
Appendix A



Invited Paper—

IEEE Journal of Solid-State Circuits, Vol. SC-9, No. 6

Abstract—A study is made of the integrated circuit operational amplifier (IC op amp) to explain details of its behavior in a simplified and understandable manner. Included are analyses of thermal feedback effects on gain, basic relationships for bandwidth and slew rate, and a discussion of pole-splitting frequency compensation. Sources of second-order bandlimiting in the amplifier are also identified and some approaches to speed and bandwidth improvement are developed. Brief sections are included on new JFET—bipolar circuitry and die area reduction techniques using transconductance reduction.

1.0 INTRODUCTION

The integrated circuit operational amplifier (IC op amp) is the most widely used of all linear circuits in production today. Over one hundred million of the devices will be sold in 1974 alone, and production costs are falling low enough so that op amps find applications in virtually every analog area. Despite this wide usage, however, many of the basic performance characteristics of the op amp are poorly understood.

It is the intent of this study to develop an understanding for op amp behavior in as direct and intuitive a manner as possible. This is done by using a variety of simplified circuit models which can be analyzed in some cases by inspection, or in others by writing just a few equations. These simplified models are generally developed from the single representative op amp configuration shown in *Figures 1 and 2*.

The rationale for starting with the particular circuit of *Figure 1* is based on the following: this circuit contains, in simplified form, all of the important elements of the most commonly used integrated op amps. It consists essentially of two voltage gain stages, an input differential amp and a common emitter second stage, followed by a class-AB output emitter follower which provides low impedance drive to the load. The two interstages are frequency compensated by a single small "pole-splitting" capacitor (see below) which is usually included on the op amp chip. In most respects this circuit is directly equivalent to the general purpose LM101 [1], μ A 741 [2], and the newer dual and quad op amps [3], so the results of our study relate directly to these devices. Even for

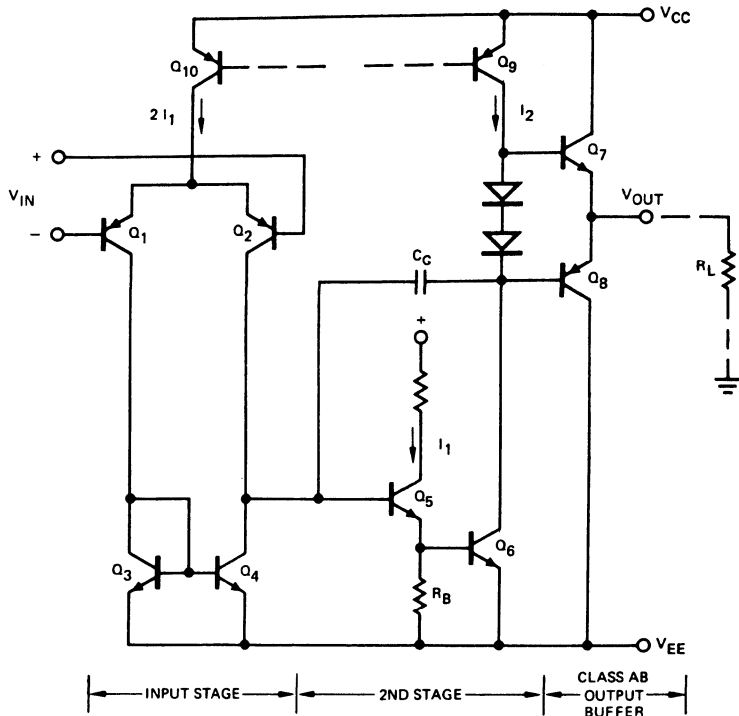
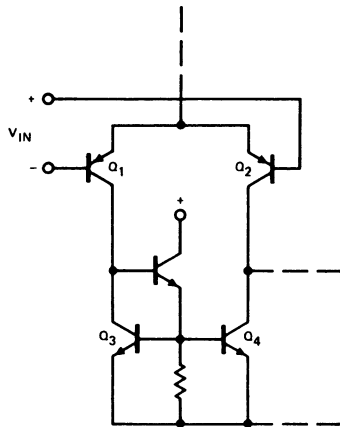


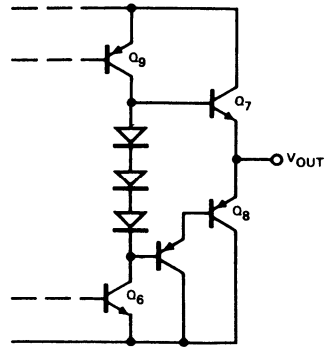
FIGURE 1. Basic two-stage IC op amp used for study. Minimal modifications used in actual IC are shown in *Figure 2*.

TL/H/8745-1



TL/H/8745-2

(a)



TL/H/8745-3

(b)

FIGURE 2. (a) Modified current mirror used to reduce dc offset caused by base currents in Q3 and Q4 in Figure 1. (b) Darlington p-n-p output stage needed to minimize gain fall-off when sinking large output currents. This is needed to offset the rapid β drop which occurs in IC p-n-p's.

more exotic designs, such as wide-band amps using feed-forward [4], [5], or the new FET input circuits [6], the basic analysis approaches still apply, and performance details can be accurately predicted. It has also been found that a good understanding of the limitations of the circuit in Figure 1 provides a reasonable starting point from which higher performance amplifiers can be developed.

The study begins in Section 2, with an analysis of dc and low frequency gain. It is shown that the gain is typically limited by thermal feedback rather than electrical characteristics. A highly simplified thermal analysis is made, resulting in a gain equation containing only the maximum output current of the op amp and a thermal feedback constant.

The next three sections apply first-order models to the calculation of small-signal high frequency and large-signal slewing characteristics. Results obtained include an accurate equation for gain-bandwidth product, a general expression for slew rate, some important relationships between slew rate and bandwidth, and a solution for voltage follower behavior in a slewing mode. Due to the simplicity of the results in these sections, they are very useful to designers in the development of new amplifier circuits.

Section 6 applies more accurate models to the calculation of important second-order effects. An effort is made in this section to isolate all of the major contributors to bandlimiting in the modern amp.

In the final section, some techniques for reduction of op amp die size are considered. Transconductance reduction and layout techniques are discussed which lead to fabrication of an extremely compact op amp cell. An example yielding 8000 possible op amps per 3-in. wafer is given.

2.0 GAIN AT DC AND LOW FREQUENCIES

A. The Electronic Gain

The electronic voltage gain will first be calculated at dc using the circuit of Figure 1. This calculation becomes straightforward if we employ the simplified transistor model shown in Figure 3(a). The resulting gain from Figure 3(b) is

$$A_v(0) = \frac{V_{out}}{V_{in}} \approx \frac{g_{m1}\beta_5\beta_6\beta_7R_L}{1 + r_{i2}/r_{o1'}} \quad (1)$$

where

$$r_{i2} \approx \beta_5(r_{e5} + \beta_6r_{e6})$$

$$r_{o1'} \approx r_{o4}/r_{o2}.$$

It has been assumed that

$$\beta_7R_L < r_{o6}/r_{o9}, g_{m1} = g_{m2}, \beta_7 = \beta_8.$$

The numerical subscripts relate parameters to transistor Q numbers (i.e., r_{e5} is r_e of Q5, β_6 is β_0 of Q6, etc.). It has also been assumed that the current mirror transistors Q3 and Q4 have α 's of unity, and the usually small loading of R_B has been ignored. Despite the several assumptions made in obtaining this simple form for (1), its accuracy is quite adequate for our needs.

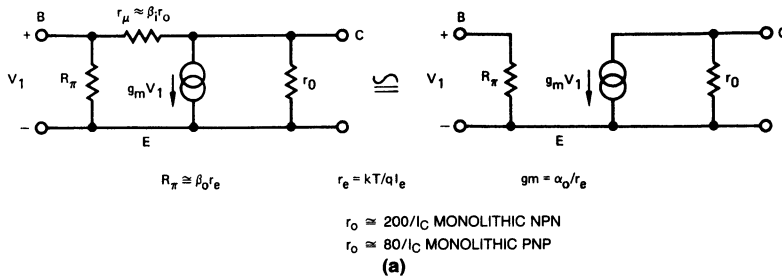
An examination of (1) confirms the way in which the amplifier operates: the input pair and current mirror convert the input voltage to a current $g_{m1}V_{in}$ which drives the base of the second stage. Transistors Q5, Q6, and Q7 simply multiply this current by β^3 and supply it to the load R_L . The finite output resistance of the first stage causes some loss when compared with second stage input resistance, as indicated by the term $1/(1 + r_{i2}/r_{o1'})$. A numerical example will help our perspective: for the LM101A, $I_1 \approx 10 \mu A$, $I_2 \approx 300 \mu A$, $\beta_5 = \beta_6 \approx 150$, and $\beta_7 \approx 50$. From (1) and dc voltage gain with $R_L = 2 \text{ k}\Omega$ is

$$A_v(0) \approx 625,000 \quad (2)$$

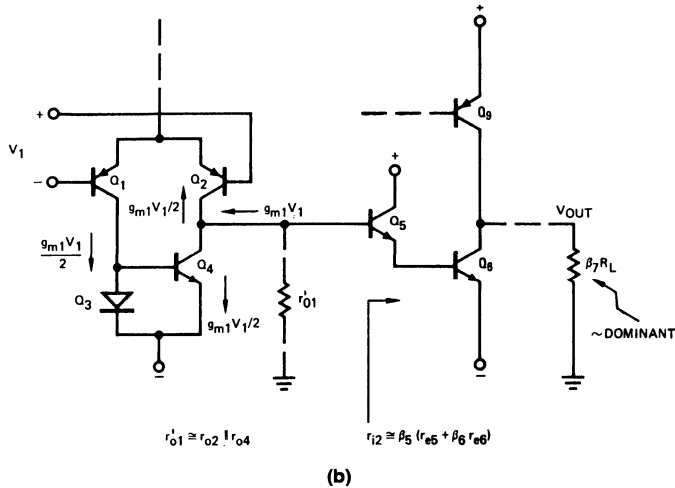
The number predicted by (2) agrees well with that measured on a discrete breadboard of the LM101A, but is much higher than that observed on the integrated circuit. The reason for this is explained in the next section.

B. Thermal Feedback Effects on Gain

The typical IC op amp is capable of delivering powers of 50–100 mW to a load. In the process of delivering this power, the output stage of the amp internally dissipates similar power levels, which causes the temperature of the IC chip to rise in proportion to the output dissipated power. The silicon chip and the package to which it is bonded are good thermal conductors, so the whole chip tends to rise to the same temperature as the output stage. Despite this, small



TL/H/8745-4



TL/H/8745-5

FIGURE 3. (a) Approximate π model for CE transistor at dc. Feedback element $r_{\mu} \cong \beta_4 r_o$ is ignored since this greatly simplifies hand calculations. The error caused is usually less than 10 percent because β_4 , the intrinsic β under the emitter, is quite large. Base resistance r_x is also ignored for simplicity. (b) Circuit illustrating calculation of electronic gain for op amp of Figure 1. Consideration is given only to the fully loaded condition ($R_L \cong 2 \text{ k}\Omega$) where β_7 is falling (to about 50) due to high current density. Under this condition, the output resistance of Q6 and Q9 are nondominant.

temperature gradients from a few tenths to a few degrees centigrade develop across the chip with the output section being hotter than the rest. As illustrated in Figure 4, these temperature gradients appear across the input components of the op amp and induce an input voltage which is proportional to the output dissipated power.

To a first order, it can be assumed that the temperature difference ($T_2 - T_1$) across a pair of matched and closely spaced components is given simply by

$$(T_2 - T_1) \cong \pm K_T P_d \quad ^\circ\text{C} \quad (3)$$

where

P_d power dissipated in the output circuit,

K_T a constant with dimensions of $^\circ\text{C}/\text{W}$.

The plus/minus sign is needed because the direction of the thermal gradient is unknown. In fact, the sign may reverse polarity during the output swing as the dominant source of heat shifts from one transistor to another. If the dominant input components consist of the differential transistor pair of Figure 4, the thermally induced input voltage V_{int} can be calculated as

$$\begin{aligned} V_{\text{int}} &\cong \pm K_T P_d (2 \times 10^{-3}) \\ &\cong \pm \gamma_T P_d \end{aligned} \quad (4)$$

where $\gamma_T = K_T (2 \times 10^{-3}) \text{ V/W}$, since the transistor emitter-base drops change about $-2 \text{ mV}/^\circ\text{C}$.

For a thermally well designed IC op amp, in which the power output devices are made to approximate either a point or a line source and the input components are placed on the resulting isothermal lines (see below and Figure 8), typical values measured for K_T are

$$K_T \cong 0.3^\circ\text{C}/\text{W} \quad (5)$$

in a TO-5 package.

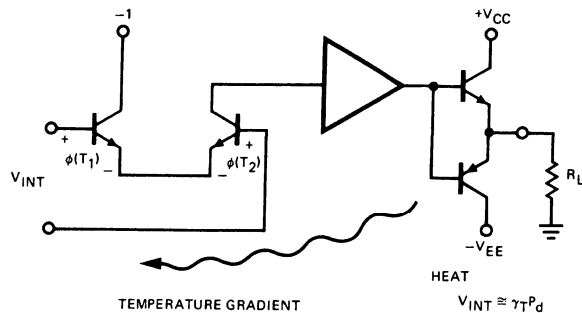
The dissipated power in the class-AB output stage P_d is written by inspection of Figure 4:

$$P_d = \frac{V_0 V_s - V_0^2}{R_L} \quad (6)$$

where

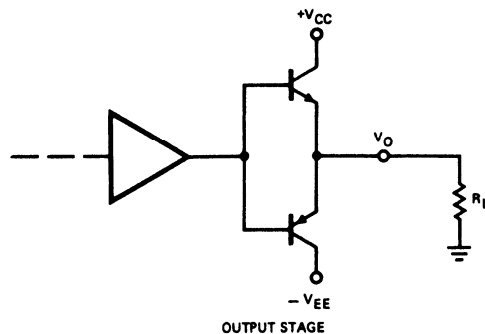
$$\begin{aligned} V_s &= +V_{cc} \quad \text{when } V_0 > 0 \\ V_s &= -V_{ee} \quad \text{when } V_0 < 0. \end{aligned}$$

A plot of (6) is Figure 5 resembles the well-known class-AB dissipation characteristics, with zero dissipation occurring



TL/H/8745-6

FIGURE 4. Simple model illustrating thermal feedback in an IC op amp having a single dominant source of self-heat, the output stage. The constant $\gamma_T \approx 0.6 \text{ mV/W}$ and P_d is power dissipated in the output. For simplicity, we ignore input drift due to uniform heating of the package. This effect can be significant if the input stage drift is not low, see [7].



TL/H/8745-7

FIGURE 5. Simple class-B output stage and plot of power dissipated in the stage, P_d , assuming device can swing to the power supplies. Equation (6) gives an expression for the plot.

for $V_O = 0, +V_{CC}, -V_{EE}$. Dissipation peaks occur for $V_O = +V_{CC}/2$ and $-V_{EE}/2$. Note also from (4) that the thermally induced input voltage V_{int} has this same double-humped shape since it is just equal to a constant times P_d at dc.

Now examine *Figures 6(a) and (b)* which are curves of open-loop V_O versus V_{in} for the IC op amp. Note first that the overall curve can be visualized to be made up of two components: a) a normal straight line electrical gain curve of the sort expected from (1) and b) a double-humped curve similar to that of *Figure 5*. Further, note that the gain characteristic has either positive or negative slope depending on the value of output voltage. This means that the thermal feedback causes the open-loop gain of the feedback amplifier to change phase by 180° , apparently causing negative feedback to become positive feedback. If this is really true, the question arises: which input should be used as the inverting one for feedback? Further, is there any way to close

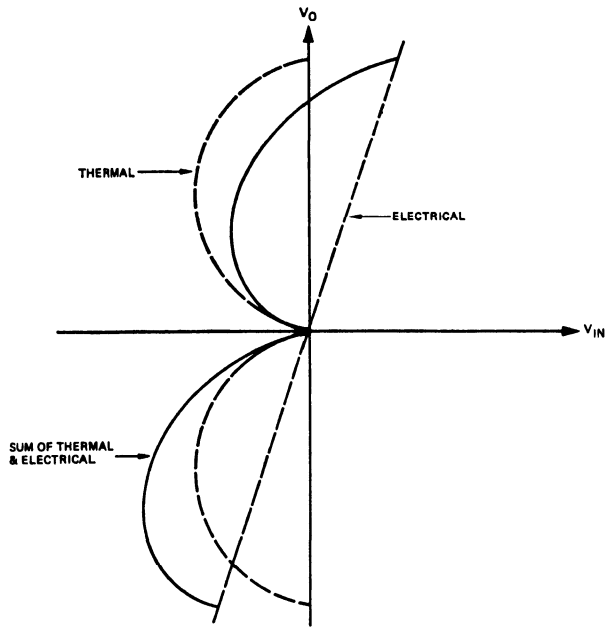
the amplifier and be sure it will not find an unstable operating point and latch to one of the power supplies?

The answers to these questions can be found by studying a simple model of the op amp under closed-loop conditions, including the effects of thermal coupling. As shown in *Figure 7*, the thermal coupling can be visualized as just an additional feedback path which acts in parallel with the normal electrical feedback. Noting that the electrical form of the thermal feedback factor is [see (4) and (6)]

$$\beta_T = \frac{\partial V_{int}}{\partial V_O} = \pm \frac{\gamma_T}{R_L} (V_s - 2V_O). \quad (7)$$

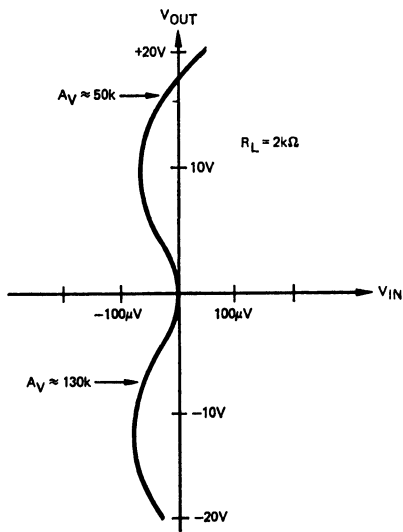
The closed-loop gain, including thermal feedback is

$$A_V(0) = \frac{\mu}{1 + \mu(\beta_e \pm \beta_T)} \quad (8)$$



(a)

TL/H/8745-8



(b)

TL/H/8745-9

FIGURE 6. (a) Idealized dc transfer curve for an IC op amp showing its electrical and thermal components. (b) Experimental open-loop transfer curve for a representative op amp (LM101).

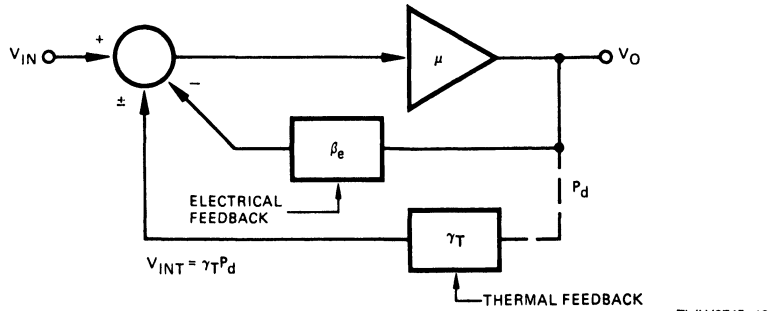


FIGURE 7. Diagram used to calculate closed-loop gain with thermal feedback.

where μ is the open-loop gain in the absence of thermal feedback [(1)] and β_e is the applied electrical feedback as in Figure 7. Inspection of (8) confirms that as long as there is sufficient electrical feedback to swamp the thermal feedback (i.e., $\beta_e > \beta_T$), the amplifier will behave as a normal closed-loop device with characteristics determined principally by the electrical feedback (i.e., $A_V(0) \approx 1/\beta_e$). On the other hand, if β_e is small or nonexistent, the thermal term in (8) may dominate, giving an apparent open-loop gain characteristic determined by the thermal feedback factor β_T . Letting $\beta_e = 0$ and combining (7) and (8), $A_V(0)$ becomes

$$A_V(0) = \frac{\mu}{1 \pm \frac{\mu\gamma_T}{R_L}(V_S - 2V_0)} \quad (9)$$

Recalling from (6) that V_0 ranges between 0 and V_S , we note that the incremental thermal feedback is greatest when $V_0 = 0$ or V_S , and it is at these points that the thermally limited gain is smallest. To use the amplifier in a predictable manner, one must always apply enough electrical feedback to reduce the gain below this minimum thermal gain. Thus, a *maximum usable gain* can be defined as that approximately equal to the value of (9) with $V_0 = 0$ or V_S which is

$$A_V(0)|_{\max} \approx \frac{R_L}{\gamma_T V_S} \quad (10)$$

or

$$A_V(0)|_{\max} \approx \frac{1}{\gamma_T I_{\max}} \quad (11)$$

It was assumed in (10) and (11) that thermal feedback dominates over the open-loop electrical gain, μ . Finally, in (11) a maximum current was defined $I_{\max} = V_S/R_L$ as the maximum current which would flow if the amplifier output could swing all the way to the supplies.

Equation (11) is a strikingly simple and quite general result which can be used to predict the expected maximum usable gain for an amplifier if we know only the maximum output current and the thermal feedback constant γ_T .

Recall that typically $K_T \approx 0.3^\circ\text{C}/\text{W}$ and $\gamma_T = (2 \times 10^{-3}) K_T \approx 0.6 \text{ mV}/\text{W}$. Consider, as an example, the standard IC op amp operating with power supplies of $V_S = \pm 15\text{V}$ and a minimum load of $2 \text{ k}\Omega$, which gives $I_{\max} = 15\text{V}/2 \text{ k}\Omega = 7.5 \text{ mA}$. Then, from (11), the maximum thermally limited gain is about:

$$A_V(0)|_{\max} \approx 1/(0.6 \times 10^{-3})(7.5 \times 10^{-3}) \approx 220,000. \quad (12)$$

Comparing (2) and (12), it is apparent that the thermal characteristics dominate over the electrical ones if the minimum

load resistor is used. For loads of $6 \text{ k}\Omega$ or more, the electrical characteristics should begin to dominate if thermal feedback from sources other than the output stage is negligible. It should be noted also that, in some high speed, high drain op amps, thermal feedback from the second stage dominates when there is no load.

As a second example, consider the so-called "power op amp" or high gain audio amp which suffers from the same thermal limitations just discussed. For a device which can deliver 1W into a 16Ω load, the peak output current and voltage are 350 mA and 5.7V . Typically, a supply voltage of about 16V is needed to allow for the swing loss in the IC output stage. I_{\max} is then $8\text{V}/16\Omega$ or 0.5A . If the device is in a TO-5 package γ_T is approximately $0.6 \text{ mV}/\text{W}$, so from (11) the maximum usable dc gain is

$$A_V(0)|_{\max} \approx \frac{1}{(0.6 \times 10^{-3})(0.5)} \approx 3300. \quad (13)$$

This is quite low compared with electrical gains of, say, $100,000$ which are easily obtainable. The situation can be improved considerably by using a large die to separate the power devices from the inputs and carefully placing the inputs on constant temperature (isothermal) lines as illustrated in Figure 8. If one also uses a power package with a

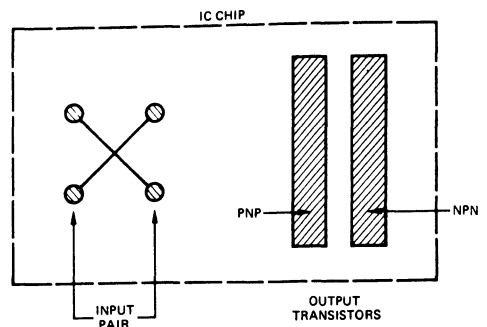
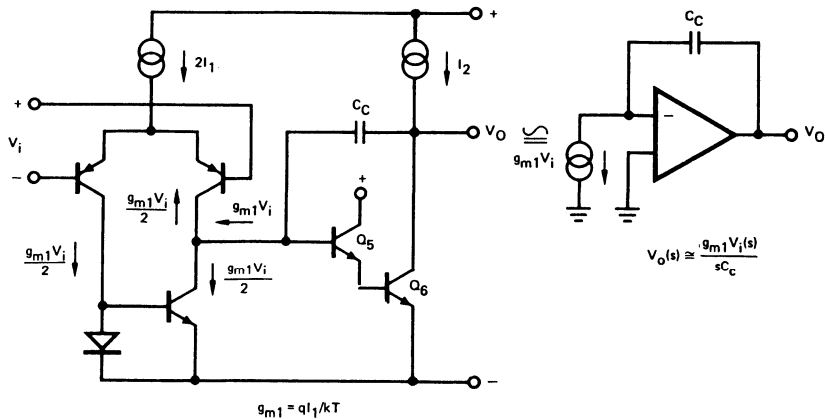


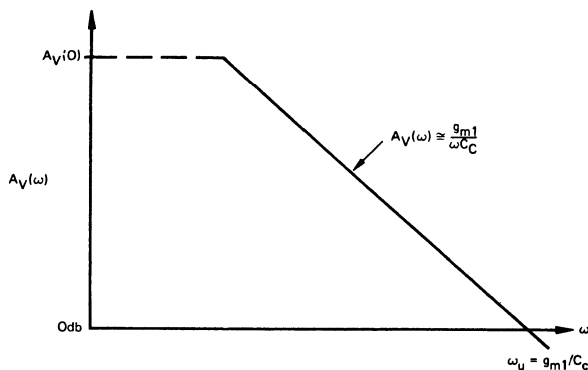
FIGURE 8. One type layout in which a quad of input transistors is cross connected to reduce effect of nonuniform thermal gradients. The output transistors use distributed stripe geometrics to generate predictable isothermal lines.

heavy copper base, γ_T 's as low as $50 \mu\text{V}/\text{W}$ have been observed. For example, a well-designed 5W amplifier driving an 8Ω load and using a 24V supply, would have a maximum gain of $13,000$ in such a power package.



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FIGURE 9. First-order model of op amp used to calculate small signal high frequency gain. At frequencies of interest the input impedance of the second stage becomes low compared to first stage output impedance due to C_c feedback. Because of this, first stage output impedance can be assumed infinite, with no loss in accuracy.



TL/H/8745-13

FIGURE 10. Plot of open-loop gain calculated from model in Figure 9. The dc and LF gain are given by (10), or (11) if thermal feedback dominates.

As a final comment, it should be pointed out that the most commonly observed effect of thermal feedback in high gain circuits is low frequency distortion due to the nonlinear transfer characteristic. Differential thermal coupling typically falls off at an initial rate of 6 dB/octave starting around 100–200 Hz, so higher frequencies are unaffected.

3.0 SMALL-SIGNAL FREQUENCY RESPONSE

At higher frequencies where thermal effects can be ignored, the behavior of the op amp is dependent on purely electronic phenomena. Most of the important small and large signal performance characteristics of the classical IC op amp can be accurately predicted from very simple first-order models for the amplifier in Figure 1 (8). The small-signal model that is used assumes that the input differential amplifier and current mirror can be replaced by a frequency independent voltage controlled current source, see Figure 9. The second stage consisting essentially of transistors Q_5 and Q_6 , and the current source load, is modeled as an ideal frequency independent amplifier block with a feedback or “integrating capacitor” identical to the compensation capacitor, C_c . The

output stage is assumed to have unity voltage gain and is ignored in our calculations. From Figure 9, the high frequency gain is calculated by inspection:

$$A_V(\omega) = \left| \frac{V_0}{V_i}(s) \right| = \left| \frac{g_{m1}}{sC_c} \right| = \frac{g_{m1}}{\omega C_c} \quad (14)$$

where dc and low frequency behavior have not been included since this was evaluated in the last section. Figure 10 is a plot of the gain magnitude as predicted by (14). From this figure it is a simple matter to calculate the open-loop unity gain frequency ω_u , which is also the gain-bandwidth product for the op amp under closed-loop conditions:

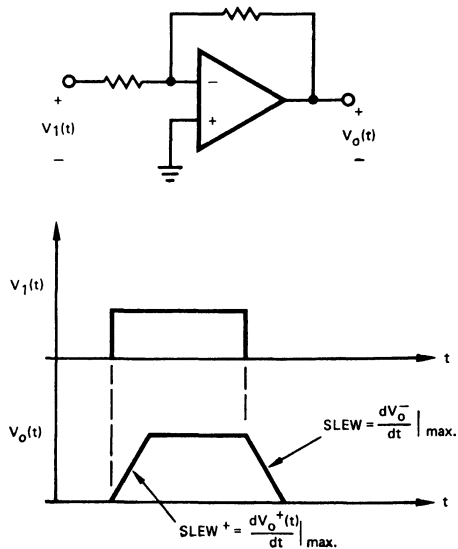
$$\omega_u = \frac{g_{m1}}{C_c} \quad (15)$$

In a practical amplifier, ω_u is set to a low enough frequency (by choosing a large C_c) so that negligible excess phase over the 90° due to C_c has built up. There are numerous contributors to excess phase including low f_t p-n-p's, stray capacitances, nondominant second stage poles, etc.

These are discussed in more detail in a later section, but for now suffice it to say that, in the simple IC op amp, $\omega_u/2\pi$ is limited to about 1 MHz. As a simple test of (15), the LM101 or the $\mu A741$ has a first stage bias current I_1 of $10 \mu A$ per side, and a compensation capacitor for unity gain operation, C_c , of 30 pF . These amplifiers each have a first stage g_m which is half that of the simple differential amplifier in Figure 1 so $g_{m1} = qI_1/2kT$. Equation (15) then predicts a unity gain corner of

$$f_u = \frac{\omega_u}{2\pi} = \frac{g_{m1}}{2\pi C_c} = \frac{(0.192 \times 10^{-3})}{2\pi(30 \times 10^{-12})} = 1.02 \text{ MHz} \quad (16)$$

which agrees closely with the measured values.



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FIGURE 11. Large signal "slewing" response observed if the input is overdriven.

4.0 SLEW RATE AND SOME SPECIAL LIMITS

A. A General Limit on Slew Rate

If an op amp is overdriven by a large-signal pulse or square wave having a fast enough rise time, the output does not follow the input immediately. Instead, it ramps or "slews" at some limiting rate determined by internal currents and capacitances, as illustrated in Figure 11. The magnitude of input voltage required to make the amplifier reach its maximum slew rate varies, depending on the type of input stage used. For an op amp with a simple input differential amp, an input of about 60 mV will cause the output to slew at 90 percent of its maximum rate, while a $\mu A741$, which has half the input g_m , requires 120 mV . High speed amplifiers such as the LM118 or a FET-input circuit require much greater overdrive, with $1-3 \text{ V}$ being common. The reasons for these overdrive requirements will become clear below.

An adequate model to calculate slew limits for the representative op amp in the inverting mode is shown in Figure 12, where the only important assumption made is that $I_2 \geq 2I_1$ in Figure 1. This condition always holds in a well-designed op amp. (If one lets I_2 be less than $2I_1$, the slew is limited by I_2 rather than I_1 , which results in lower speed than is otherwise possible.) Figure 12 requires some modification for noninverting operation, and we will study this later.

The limiting slew rate is now calculated from Fig. 12. Letting the input voltage be large enough to fully switch the input differential amp, we see that all of the first stage tail current $2I_1$ is simply diverted into the integrator consisting of A and C_c . The resulting slew rate is then:

$$\text{slew rate} = \frac{dv_0}{dt} \Big|_{\text{max}} = \frac{i_c(t)}{C_c} \quad (17)$$

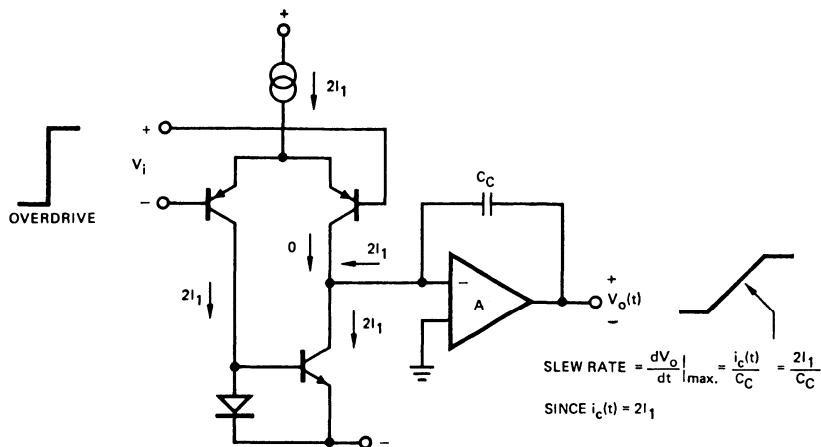
Noting that $i_c(t)$ is a constant $2I_1$, this becomes

$$\frac{dv_0}{dt} \Big|_{\text{max}} = \frac{2I_1}{C_c} \quad (18)$$

As a check of this result, recall that the $\mu A741$ has $I_1 = 10 \mu A$ and $C_1 = 30 \text{ pF}$, so we calculate:

$$\frac{dv_0}{dt} \Big|_{\text{max}} = \frac{2 \times 10^{-5}}{30 \times 10^{-12}} = 0.67 \frac{V}{\mu s} \quad (19)$$

which agrees with measured values.



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FIGURE 12. Model used to calculate slew rate for the amp of Figure 1 in the inverting mode. For simplicity, all transistor α 's are assumed equal to unity, although results are essentially independent of α . An identical slew rate can be calculated for a negative-going output, obtained if the applied input polarity is reversed.

The large and small signal behavior of the op amp can be usefully related by combining (15) for ω_u with (18). The slew rate becomes

$$\left. \frac{dv_0}{dt} \right|_{\max} = \frac{2\omega_u I_1}{g_{m1}} \quad (20)$$

Equation (20) is a general and very useful relationship. It shows that, for a given unity-gain frequency, ω_u , the slew rate is determined entirely by just the ratio of first stage operating current to first stage transconductance, I_1/g_{m1} . Recall that ω_u is set at the point where excess phase begins to build up, and this point is determined largely by technology rather than circuit limitations. Thus, the only effective means available to the circuit designer for increasing op amp slew rate is to *decrease* the ratio of first stage transconductance to operating current, g_{m1}/I_1 .

B. Slew Limiting for Simple Bipolar Input Stage

The significance of (20) is best seen by considering the specific case of a simple differential bipolar input as in *Figure 1*. For this circuit, the first stage transconductance (for $\alpha_1 = 1$) is¹

$$g_{m1} = qI_1/kT \quad (21)$$

so that

$$\frac{g_{m1}}{I_1} = q/kT \quad (22)$$

Using this in (20), the maximum bipolar slew rate is

$$\left. \frac{dv_0}{dt} \right|_{\max} = 2\omega_u \frac{kT}{q} \quad (23)$$

This provides us with the general (and somewhat dismal) conclusion that slew rate in an op amp with a simple bipolar input stage is dependent only upon the unity gain corner and fundamental constants. Slew rate can be increased only by increasing the unity gain corner, which we have noted is generally difficult to do. As a demonstration of the severity of this limit, imagine an op amp using highly advanced technology and clever design, which might have a stable unity gain frequency of 100 MHz. Equation (23) predicts that the slew rate for this advanced device is only

$$\left. \frac{dv_0}{dt} \right|_{\max} = 33 \frac{V}{\mu s} \quad (24)$$

which is good, but hardly impressive when compared with the difficulty of building a 100 MHz op amp.² But, there are some ways to get around this limit as we shall see shortly.

C. Power Bandwidth

Our intuition regarding slew rate will be enhanced somewhat if we relate it to a term called "power bandwidth". Power bandwidth is defined as the maximum frequency at which full output swing (usually 10V peak) can be obtained without distortion. For a sinusoidal output voltage $v_0(t) = V_p \sin \omega t$, the rate of change of output, or slew rate, required to reproduce the output is

$$\frac{dv_0}{dt} = \omega V_p \cos \omega t \quad (25)$$

This has a maximum when $\cos \omega t = 1$ giving

$$\left. \frac{dv_0}{dt} \right|_{\max} = \omega V_p \quad (26)$$

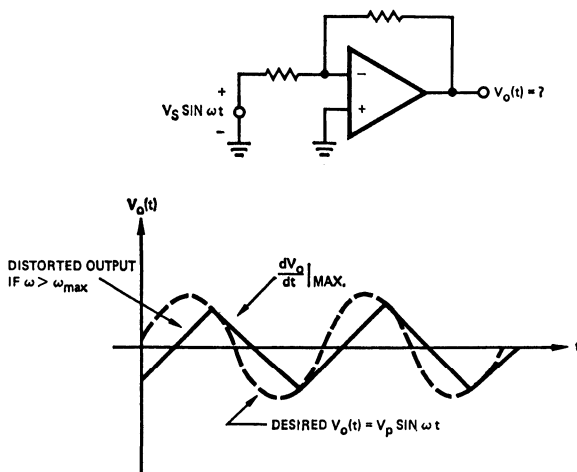
so the highest frequency that can be reproduced without slew limiting, ω_{\max} (power bandwidth) is

$$\omega_{\max} = \frac{1}{V_p} \left. \frac{dv_0}{dt} \right|_{\max} \quad (27)$$

Thus, power bandwidth and slew rate are directly related by the inverse of the peak of the sine wave V_p . *Figure 13* shows the severe distortion of the output sine wave which results if one attempts to amplify a sine wave which results if one attempts to amplify a sine wave of frequency $\omega > \omega_{\max}$.

¹Note that (21) applies only to the simple differential input stage of *Figure 12*. For compound input stages as in the LM101 or $\mu A741$, g_{m1} is half that in (21), and the slew rate in (23) is doubled.

²We assume in all of these calculations that C_C is made large enough so that the amplifier has less than 180° phase lag at ω_u , thus making the amplifier stable for unity closed-loop gain. For higher gains one can of course reduce C_C (if the IC allows external compensation) and increase the slew rate according to (18).



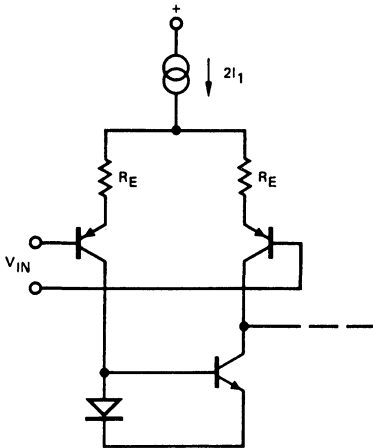
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FIGURE 13. Slew limiting effects on output sinewave that occur if frequency is greater than power bandwidth, ω_{\max} . The onset of slew limiting occurs very suddenly as ω reaches ω_{\max} . No distortion occurs below ω_{\max} , while almost complete triangularization occurs at frequencies just slightly above ω_{\max} .

Some numbers illustrate typical op amp limits. For a μ A741 or LM101 having a maximum slew rate of $0.67\text{V}/\mu\text{s}$, (27) gives a maximum frequency for an undistorted 10V peak output of

$$f_{\max} = \frac{\omega_{\max}}{2\pi} = 10.7 \text{ kHz}, \quad (28)$$

which is a quite modest frequency considering the much higher frequency small signal capabilities of these devices. Even the highly advanced 100 MHz amplifier considered above has a 10V power bandwidth of only 0.5 MHz, so it is apparent that a need exists for finding ways to improve slew rate.



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FIGURE 14. Resistive degeneration used to provide slew rate enhancement according to (29).

D. Techniques for Increasing Slew Rate

1) *Resistive Enhancement of the Bipolar Stage:* Equation (20) indicates that slew rate can be improved if we reduce first stage g_{m1}/I_1 . One of the most effective ways of doing this is shown in *Figure 14*, where simple resistive emitter degeneration has been added to the input differential amplifier (8). With this change, the g_{m1}/I_1 drops to

$$\frac{g_{m1}}{I_1} = \frac{38.5}{1 + T_E I_1 / 26 \text{ mV}} \quad (29)$$

at 25°C

The quantity g_{m1}/I_1 is seen to decrease rapidly with added R_E as soon as the voltage drop across R_E exceeds 26 mV. The LM118 is a good example of a bipolar amplifier which uses emitter degeneration to enhance slew rate [4]. This device uses emitter resistors to produce $R_E I_1 = 500 \text{ mV}$, and has a unity gain corner of 16 MHz. Equations (20) and (29) then predict a maximum inverting slew rate of

$$\left. \frac{dv_0}{dt} \right|_{\max} = 2\omega_u \frac{I_1}{g_{m1}} = \omega_u = 100 \frac{\text{V}}{\mu\text{s}} \quad (30)$$

which is a twenty-fold improvement over a similar amplifier without emitter resistors.

A penalty is paid in using resistive slew enhancement, however. The two added emitter resistors must match extremely well or they add voltage offset and drift to the input. In the LM118, for example, the added emitter R's have values of

$2.0 \text{ k}\Omega$ each and these contribute an input offset of 1 mV for each 4Ω (0.2 percent) of mismatch. The thermal noise of the resistors also unavoidably degrades noise performance.

2) *Slew Rate in the FET Input Op Amp:* The FET (JFET or MOSFET) has a considerably lower transconductance than a bipolar device operating at the same current. While this is normally considered a drawback of the FET, we note that this "poor" behavior is in fact highly desirable in applications to fast amplifiers. To illustrate, the drain current for a JFET in the "current saturation" region can be approximated by

$$I_D \approx I_{DSS} (V_{GS}/V_T - 1)^2 \quad (31)$$

where

I_{DSS} the drain current for $V_{GS} = 0$,

V_{GS} the gate source voltage having positive polarity for forward gate-diode bias,

V_T the threshold voltage having negative polarity for JFET's.

The small-signal transconductance is obtained from (31) as $g_m = \partial I_D / \partial V_{GS}$. Dividing by I_D and simplifying, the ratio g_m/I_D for a JFET is

$$\frac{g_m}{I_D} \approx \frac{2}{(V_{GS} - V_T)} = \frac{2}{-V_T} \left[\frac{I_{DSS}}{I_D} \right]^{1/2} \quad (32)$$

Maximum amplifier slew rate occurs for minimum g_m/I_D and, from (32), this occurs when I_D or V_{GS} is maximum. Normally it is impractical to forward bias the gate junction so a practical minimum occurs for (32) when $V_{GS} \approx 0\text{V}$ and $I_D \approx I_{DSS}$. Then

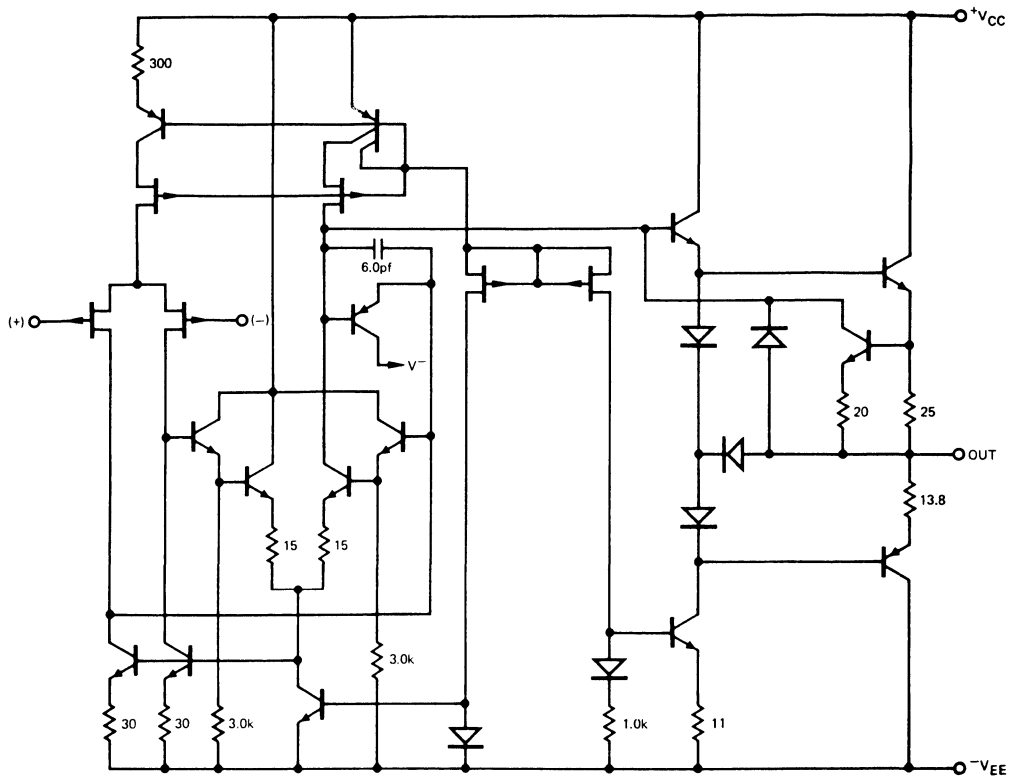
$$\left. \frac{g_m}{I_D} \right|_{\min} \approx -2 \frac{2}{V_T} \quad (33)$$

Comparing (33) with the analogous bipolar expression, (22), we find from (20) that the JFET slew rate is greater than bipolar by the factor

$$\frac{\text{JFET slew}}{\text{bipolar slew}} \approx \frac{-V_T 2 \omega_{uf}}{2kT/q\omega_{ub}} \quad (34)$$

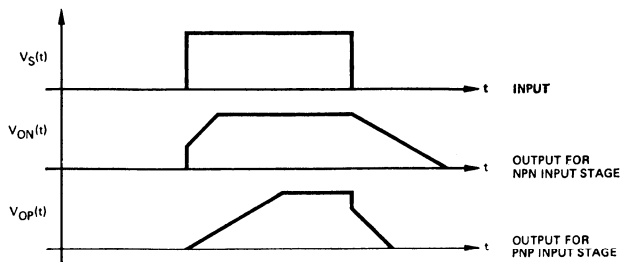
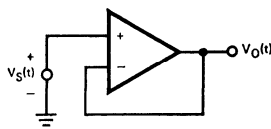
where ω_{uf} and ω_{ub} are unity-gain bandwidths for JFET and bipolar amps, respectively. Typical JFET thresholds are around 2V ($V_T = -2\text{V}$), so for equal bandwidths (34) tells us that a JFET-input op amp is about forty times faster than a simple bipolar input. Further, if JFET's are properly substituted for the slow p-n-p's in a monolithic design, bandwidth improvements by at least a factor of ten are obtainable. JFET-input op amps, therefore, offer slew rate improvements by better than two orders of magnitude when compared with the conventional IC op amp. (Similar improvements are possible with MOSFET-input amplifiers.) This characteristic, coupled with picoamp input currents and reasonable offset and drift, make the JFET-input op amp a very desirable alternative to conventional bipolar designs.

As an example, *Figure 15*, illustrates one design for an op amp employing compatible p-channel JFET's on the same chip with the normal bipolar components. This circuit exhibits a unity gain corner of 10 MHz, a $33 \text{ V}/\mu\text{s}$ slew rate, an input current of 10 pA and an offset voltage and drift of 3 mV and $3 \mu\text{V}/^\circ\text{C}$ [6]. Bandwidth and slew rate are thus improved over simple IC bipolar by factors of 10 and 100, respectively. At the same time input currents are smaller by about 10^3 , and offset voltages and drifts are comparable to or better than slew enhanced bipolar circuits.



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FIGURE 15. Monolithic operational amplifier employing compatible p-channel JFET's on the same chip with normal bipolar components.



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FIGURE 16. Large signal response of the voltage follower. For an op amp with simple n-p-n input stage we get the waveform $v_{ON}(t)$, which exhibits a step slew "enhancement" on the positive going output, and a slew "degradation" on the negative going output. For a p-n-p input stage, these effects are reversed as shown by $v_{OP}(t)$.

5.0 SECOND-ORDER EFFECTS: VOLTAGE FOLLOWER SLEW BEHAVIOR

If the op amp is operated in the noninverting mode and driven by a large fast rising input, the output exhibits the characteristic waveform in *Figure 16*. As shown, this waveform does not have the simple symmetrical slew characteristic of the inverter. In one direction, the output has a fast step (slew "enhancement") followed by a "normal" inverter slewing response. In the other direction, it suffers a slew "degradation" or reduced slope when compared with the inverter slewing response.

We will first study slew degradation in the voltage follower connection, since this represents a worst case slewing condition for the op amp. A model which adequately represents the follower under large-signal conditions can be obtained from that in *Figure 12* by simply tying the output to the inverting input, and including a capacitor C_S to account for the presence of any capacitance at the output of the first stage (tail) current source, see *Figure 17*. This "input tail" capacitance is important in the voltage follower because the input stage undergoes rapid large-signal excursions in this connection, and the charging currents in C_S can be quite large.

Circuit behavior can be understood by analyzing *Figure 17* as follows. The large-signal input step causes Q_1 to turn OFF, leaving Q_2 to operate as an emitter follower with its emitter tracking the variational output voltage, $v_0(t)$. It is seen that $v_0(t)$ is essentially the voltage appearing across both C_S and C_C so we can write

$$\frac{dv_0}{dt} \cong \frac{i_c}{C_C} \cong \frac{i_s}{C_S} \quad (35)$$

Noting that $i_c \cong 2I_1 - i_s$ (unity α 's assumed), (35) can be solved for i_s :

$$i_s \cong \frac{2I_1}{1 + C_C/C_S} \quad (36)$$

which is seen to be constant with time. The degraded voltage follower slew rate is then obtained by substituting (36) into (35):

$$\left. \frac{dv_0}{dt} \right|_{\text{degr}} \cong \frac{i_s}{C_S} \cong \frac{2I_1}{C_C + C_S} \quad (37)$$

Comparing (37) with the slew rate for the inverter, (18), it is seen that the slew rate is reduced by the simple factor $1/(1 + C_S/C_C)$. As long as the input tail capacitance C_S is small compared with the compensation amplifiers where C_C is small, degradation becomes quite noticeable, and one is encouraged to develop circuits with small C_S .

As an example, consider the relatively fast LM118 which has $C_C \cong 5$ pF, $C_S \cong 2$ pF, $2I_1 = 500$ μ A. The calculated inverter slew rate is $2I_1/C_C \cong 100V/\mu$ s, and the degraded voltage follower slew rate is found to be $2I_1/(C_C + C_S) \cong 70V/\mu$ s. The slow degradation is seen to be about 30 percent, which is very significant. By contrast a μ A741 has $C_C \cong 30$ pF and $C_S \cong 4$ pF which results in a degradation of less than 12 percent.

The slow "enhanced waveform can be similarly predicted from a simplified model. By reversing the polarity of the input and initially assuming a finite slope on the input step, the enhanced follower is analyzed, as shown in *Figure 18*. Noting that Q_1 is assumed to be turned ON by the step input and Q_2 is OFF, the output voltage becomes

$$v_0(t) \cong -\frac{1}{C_C} \int_0^t [2I_1 + i_s(t)] dt \quad (38)$$

The voltage at the emitter of Q_1 is essentially the same as the input voltage, $v_i(t)$, so the current in the "tail" capacitance C_B is

$$i_s(t) \cong C_B \frac{dv_i}{dt} \cong \frac{C_B V_{ip}}{t_1} \quad 0 < t < t_1 \quad (39)$$

Combining (38) and (39), $v_0(t)$ is

$$-v_0(t) \cong \frac{1}{C_C} \int_0^t 2I_1 dt + \frac{1}{C_C} \int_0^{t_1} \frac{C_B V_{ip}}{t_1} dt \quad (40)$$

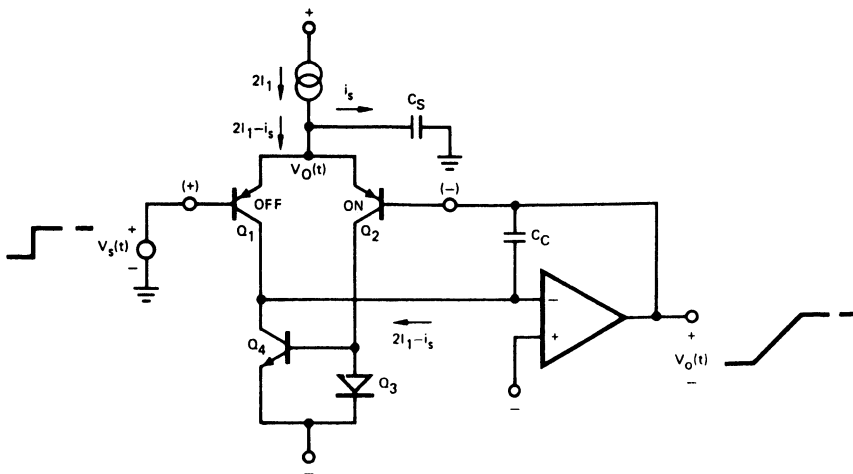
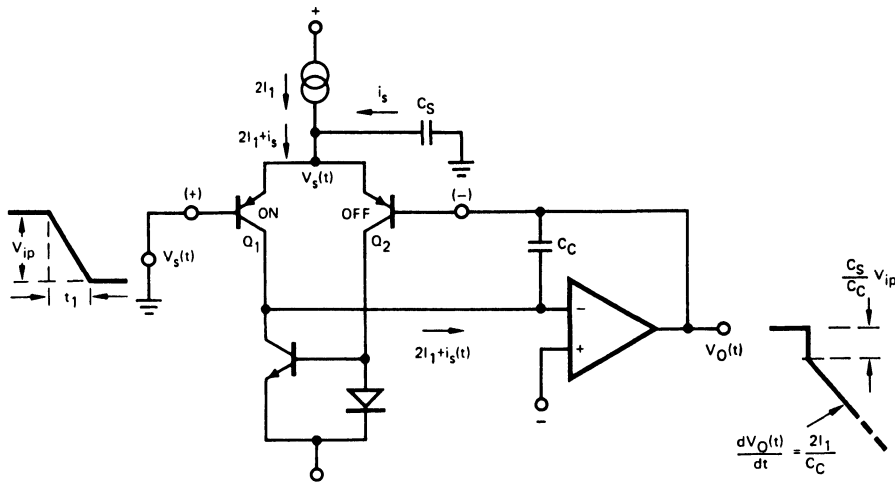


FIGURE 17. Circuit used for calculation of slew "degradation" in the voltage follower. The degradation is caused by the capacitor C_B , which robs current from the tail, $2I_1$, thereby preventing the full $2I_1$ from slewing C_C .

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TL/H/8745-21

FIGURE 18. Circuit used for calculation of slew "enhancement" in the voltage follower. The fast falling input causes a step output followed by a normal slew response as shown.

or

$$-v_0(t) \cong \frac{C_B}{C_C} V_{ip} + \frac{2I_1 t}{C_C} \quad (41)$$

Equation (41) tells us that the output has an initial negative step which is the fraction C_B/C_C of the input voltage. This is followed by a normal slewing response, in which the slew rate is identical to that of the inverter, see (18). This response is illustrated in *Figure 18*.

6. LIMITATIONS ON BANDWIDTH

In earlier sections, all bandlimiting effects were ignored except that of the compensation capacitor, C_C . The unity-gain frequency was set at a point sufficiently low so that negligible excess phase (over the 90° from the dominant pole) due to second-order (high frequency) poles had built up. In this section the major second-order poles which contribute to bandlimiting in the op amp are identified.

A. The Input Stage: p-n-p's, the Mirror Pole, and the Tail Pole

For many years it was popular to identify the lateral p-n-p's (which have f_1 's $\cong 3$ MHz) as the single dominant source of bandlimiting in the IC op amp. It is quite true that the p-n-p's do contribute significant excess phase to the amplifier, but it is not true that they are the sole contributor to excess phase [9]. In the input stage, alone, there is at least one other important pole, as illustrated in *Figure 19(a)*. For the simple differential input stage driving a differential-to-single ended converter ("mirror" circuit), it is seen that the inverting signal (which is the feedback signal) follows two paths, one of which passes through the capacitance C_B , and the other through C_m . These capacitances combine with the dynamic resistances at their nodes to form poles designated the mirror pole at

$$p_m \cong \frac{I_1}{C_m kT/q}, \quad (42)$$

and the tail pole at

$$p_t \cong \frac{2I_1}{C_B kT/q}. \quad (43)$$

It can be seen that if one attempts to operate the first stage at too low a current, these poles will bandlimit the amplifier. If, for example, we choose $I_1 = 1 \mu A$, and assume $C_m \cong 7$ pF (consisting of 4 pF isolation capacitance and 3 pF emitter transition capacitance) and $C_B \cong 4$ pF, $p_m/2\pi \cong 0.9$ MHz and $p_t/2\pi \cong 3$ MHz either of which would seriously degrade the phase margin of a 1 MHz amplifier.

If a design is chosen in which either the tail pole or the mirror pole is absent (or unimportant), the remaining pole rolls off only half the signal, so the overall response contains a pole-zero pair separated by one octave. Such a pair generally has a small effect on amplifier response unless it occurs near ω_u , where it can degrade phase margin by as much as 20° .

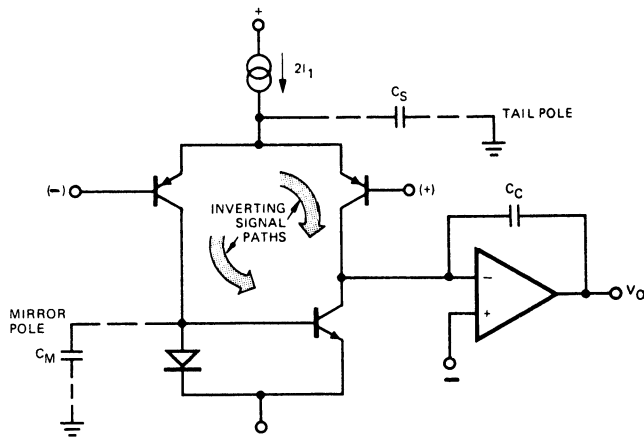
It is interesting to note that the compound input stage of the classical LM101 and $\mu A741$ has a distinct advantage over the simple differential stage, as seen in *Figure 19(b)*. This circuit is noninverting across each half, thus it provides a path in which half the feedback signal bypasses both the mirror and tail poles.

B. The Second Stage: Pole Splitting

The assumption was made in Section 3 that the second stage behaved as an ideal integrator having a single dominant pole response. In practice, one must take care in designing the second stage or second-order poles can cause significant deviation from the expected response. Considerable insight into the basic way in which the second stage operates can be obtained by performing a small-signal analysis on a simplified version of the circuit as shown in *Figure 20* [10]. A straightforward two-node analysis of *Figure 20(c)* produces the following expression for v_{out} .

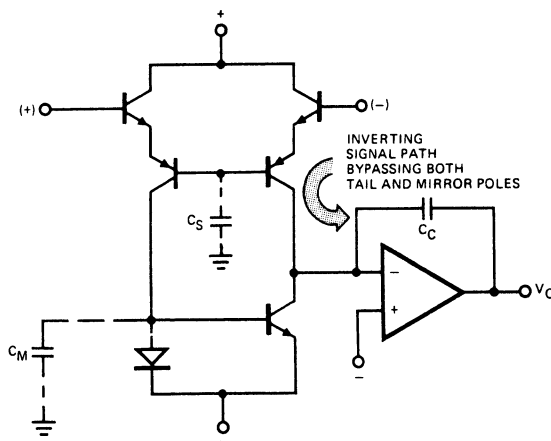
$$\frac{v_{out}}{i_s} = -g_m R_1 R_2 (1 - s C_p / g_m) \div (1 + s[R_1(C_1 + C_p) + R_2(C_2 + C_p) + g_m R_1 R_2 C_p] + s^2 R_1 R_2 [C_1 C_2 + C_p(C_1 + C_2)]). \quad (44)$$

³ C_B can have a wide range of values depending on circuit configuration. It is largest for n-p-n input differential amps since the current source has a collector-substrate capacitance ($C_B \cong 3-4$ pF at its output. For p-n-p input stages it can be as small as 1-2 pF.



(a)

TL/H/8745-22



(b)

TL/H/8745-23

FIGURE 19. (a) Circuit showing “mirror” pole due to C_m and “tail” pole due to C_b . One component of the signal due to an inverting input must pass through either the mirror or tail poles. (b) Alternate circuit to Figure 19(a) (LM101, $\mu A741$) which has less excess phase. Reason is that half the inverting signal path need not pass through the mirror pole or the tail pole.

The denominator of (44) can be approximately factored under conditions that its two poles are widely separated. Fortunately, the poles are, in fact, widely separated under most normal operating conditions. Therefore, one can assume that the denominator of (44) has the form

$$D(s) = (1 + s/p_1)(1 + s/p_2) \\ = 1 + s(1/p_1 + 1/p_2) + s^2/p_1p_2. \quad (45)$$

With the assumption that p_1 is the dominant pole and p_2 is nondominant, i.e., $p_1 \ll p_2$, (45) becomes

$$D(s) \approx 1 + s/p_1 + s^2/p_1p_2. \quad (46)$$

Equating coefficients of s in (44) and (46), the dominant pole p_1 is found directly:

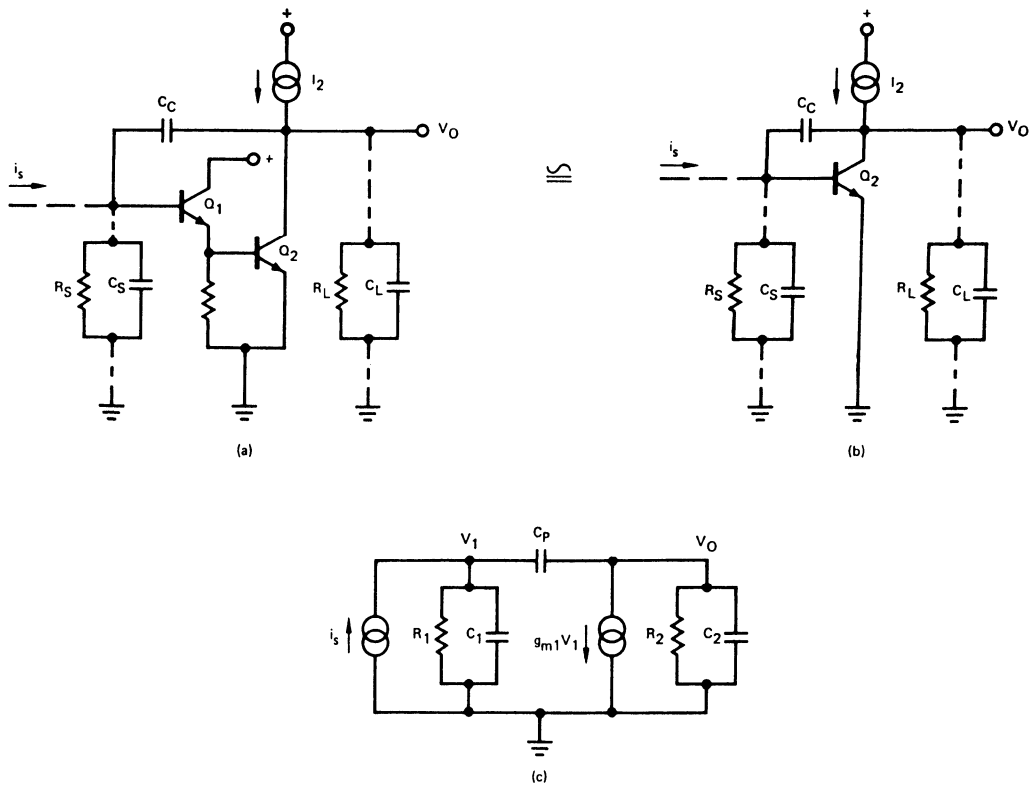
$$p_1 \approx \frac{1}{R_1(C_1 + C_p) + R_2(C_2 + C_p) + g_m R_1 R_2 C_p} \quad (47)$$

$$\approx \frac{1}{g_m R_1 R_2 C_p}. \quad (48)$$

The latter approximation (48), normally introduces little error, because the g_m term is much larger than the other two. We note at this point that p_1 , which represents the dominant pole of the amplifier, is due simply to the familiar Miller-multiplied feedback capacitance $g_m R_2 C_p$ combined with input node resistance, R_1 . The nondominant pole p_2 is found similarly by equating s^2 coefficients in (44) and (46) and dividing by p_1 from (48). The result is

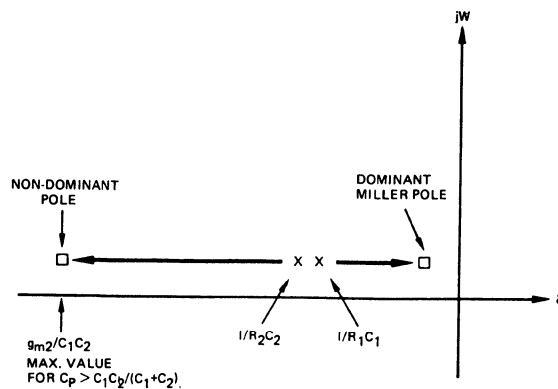
$$p_2 \approx \frac{g_m C_p}{C_1 C_2 + C_p(C_1 + C_2)}. \quad (49)$$

Several interesting things can be seen in examining (48) and (49). First, we note that p_1 is inversely proportional to g_m (and C_p), while p_2 is directly dependent on g_m (and C_p).



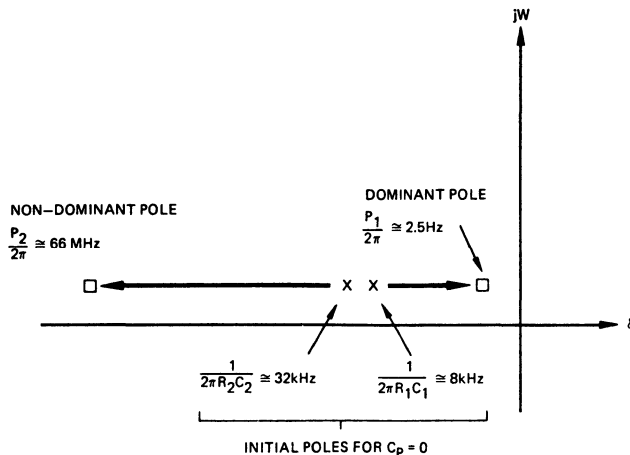
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FIGURE 20. Simplification of second stage used for pole-splitting analysis. (a) Complete second stage with input stage and output stage loading represented by R_S , C_S , and R_L , C_L respectively. (b) Emitter follower ignored to simplify analysis. (c) Hybrid π model substituted for transistor in (b). Source and load impedances are absorbed into model with the total impedances represented by R_1 , C_1 , and R_2 and C_2 . Transistor base resistance is ignored and C_P includes both C_C and transistor collector-base capacitance.



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FIGURE 21. Pole migration for second stage employing "pole-splitting" compensation. Plot is shown for increasing C_P and it is noted that the nondominant pole reaches a maximum value for large C_P .



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FIGURE 22. Example of pole-splitting compensation in the $\mu A741$ op amp. Values used in (48) and (49) are: $g_{m2} = 1/87\Omega$, $C_p = 30 \text{ pF}$, $C_1 = C_2 = 10 \text{ pF}$, $R_1 = 1.7 \text{ M}\Omega$, $R_2 = 100 \text{ k}\Omega$.

Thus, as either C_p or transistor gain are increased, the dominant pole decreases and the nondominant pole increases. The poles p_1 and p_2 are being "split-apart" by the increased coupling action in a kind of inverse root locus plot.

This *pole-splitting* action is shown in *Figure 21*, where pole migration is plotted for C_p increasing from 0 to a large value. *Figure 22* further illustrates the action by giving specific pole positions for the $\mu A741$ op amp. It is seen that the initial poles (for $C_p = 0$) are both in the tens of kHz region and these are predicted to reach 2.5 Hz ($p_1/2\pi$) and 66 MHz ($p_2/2\pi$) after compensation is applied. This result is, of course, highly satisfactory since the second stage now has a single dominant pole effective over a wide frequency band.

C. Failure of Pole Splitting

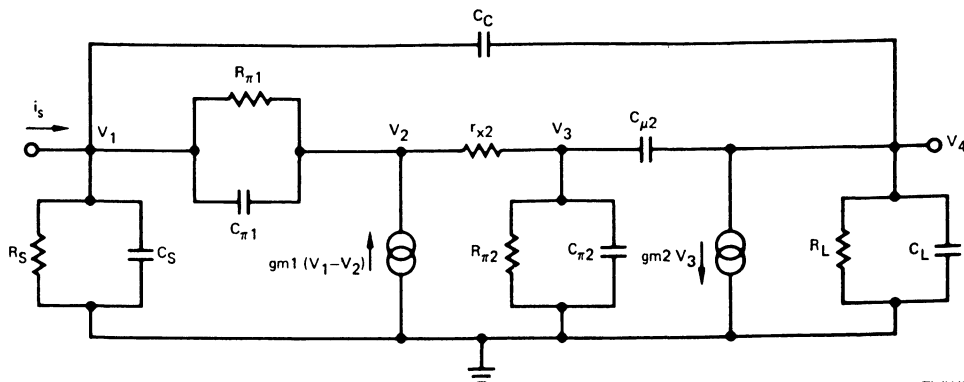
There are several situations in which the application of pole-splitting compensation may not result in a single dominant pole response. One common case occurs in very wide-band op amps where the pole-splitting capacitor is small. In this situation the nondominant pole given by (49) may not become broadbanded sufficiently so that it can be ignored. To

illustrate, suppose we attempt to minimize power dissipation by running the second stage of an LM118 (which has a small-signal bandwidth of 16 MHz) at 0.1 mA. For this op amp $C_p = 5 \text{ pF}$, $C_1 = C_2 = 10 \text{ pF}$. From (49), the nondominant pole is

$$\frac{p_2}{2\pi} \cong 16 \text{ MHz} \quad (50)$$

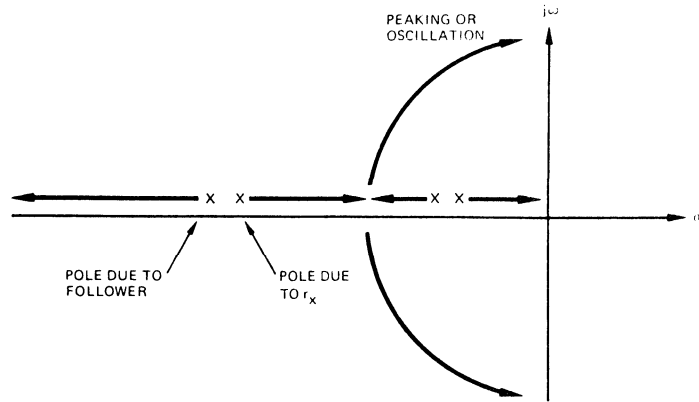
which lies right at the unity-gain frequency. This pole alone would degrade phase margin by 45° , so it is clear that we need to bias the second stage with a collector current greater than 0.1 mA to obtain adequate g_m . Insufficient pole-splitting can therefore occur; but the cure is usually a simple increase in second stage g_m .

A second type of pole-splitting failure can occur, and it is often much more difficult to cope with. If, for example, one gets over-zealous in his attempt to broadband the nondominant pole, he soon discovers that other poles exist within the second stage which can cause difficulties. Consider a more exact equivalent circuit for the second stage of *Figure 20(a)* as shown in *Figure 23*. If the follower is biased at low currents or if C_p , $Q_2 g_m$, and/or r_x are high, the circuit can contain at least four important poles rather than the two



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FIGURE 23. More exact equivalent circuit for second stage of *Figure 20(a)* including a simplified π model for the emitter follower ($R_{\pi 1}$, $C_{\pi 1}$, g_{m1}) and a complete π for Q_2 (r_{x2} , $R_{\pi 2}$, etc.).



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FIGURE 24. Root locus for second stage illustrating failure of pole splitting due to high g_{m2} , r_{x2} , C_p , and/or low bias current in the emitter follower.

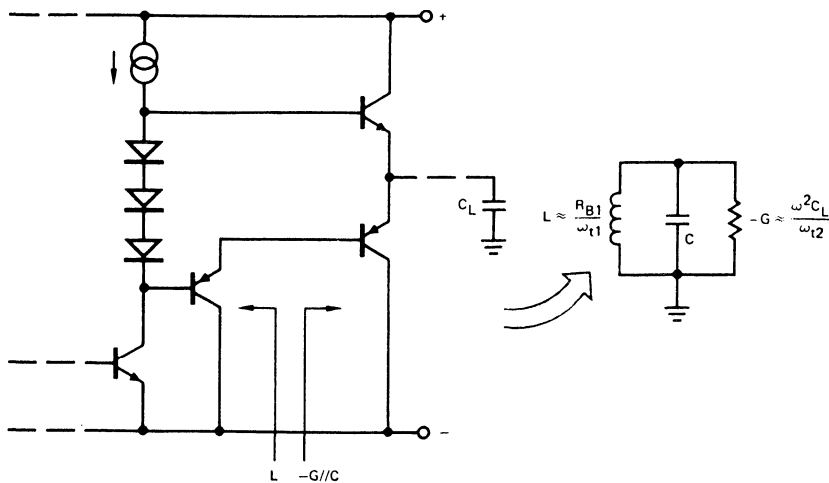
considered in simple pole splitting. Under these conditions, we no longer have a response with just negative real poles as in *Figure 21*, but observe a root locus of the sort shown in *Figure 24*. It is seen in this case that the circuit contains a pair of complex, possibly underdamped poles which, of course, can cause peaking or even oscillation. This effect occurs so commonly in the development of wide-band pole-split amplifiers that it has been (not fondly) dubbed "the second stage bump."

There are numerous ways to eliminate the "bump," but no single cure has been found which is effective in all situations. A direct hand analysis of *Figure 23* is possible, but the results are difficult to interpret. Computer analysis seems the best approach for this level of complexity, and numerous specific analyses have been made. The following is a list of circuit modifications that have been found effective in reducing the bump in various studies: 1) reduce g_{m2} , r_{x2} , $C_{\mu 2}$, 2) add capacitance or a series RC network from the stage input to ground—this reduces the high frequency local

feedback due to C_p , 3) pad capacitance at the output for similar reasons, 4) increase operating current of the follower, 5) reduce C_p , 6) use a higher f_t process.

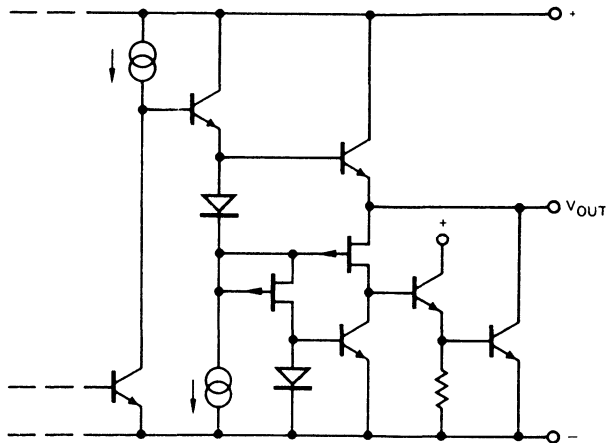
D. Troubles in the Output Stage

Of all the circuitry in the modern IC op amp, the class-AB output stage probably remains the most troublesome. None of the stages in use today behave as well as one might desire when stressed under worst case conditions. To illustrate, one of the most commonly used output stages is shown in *Figure 2(b)*. The p-n-p's in this circuit are "substrate" p-n-p's having low current f_t 's of around 20 MHz. Unfortunately, both β_0 and f_t begin to fall off rapidly at quite low current densities, so as one begins to sink just a few milliamps in the circuit, phase margin troubles can develop. The worst effect occurs when the amplifier is operated with a large capacitive load (>100 pF) while sinking high currents. As shown in *Figure 25*, the load capacitance on the



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FIGURE 25. Troubles in the conventional class-AB output stage of *Figure 2(b)*. The low f_t output p-n-p's interact with load capacitance to form the equivalent of a one-port oscillator.



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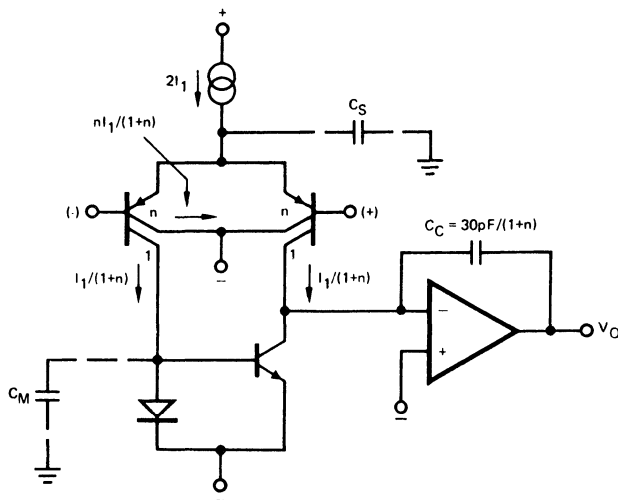
FIGURE 26. The "Bi-FET™" output stage employing JFET's and bipolar n-p-n's to eliminate sensitivity to load capacitance.

output follower causes it to have negative input conductance, while the driver follower can have an inductive output impedance. These elements combine with the capacitance at the interstage to generate the equivalent of a one-port oscillator. In a carefully designed circuit, oscillation is suppressed, but peaking (the "output bump") can occur in most amplifiers under appropriate conditions.

One new type of output circuit which does not use p-n-p's is shown in *Figure 26* [6]. This circuit employs compatible JFET's (or MOSFET's, see similar circuit in [11]) in a FET/bipolar quasi-complementary output stage, which is insensitive to load capacitance. Unfortunately, this circuit is rather complex and employs extra process steps, so it does not appear to represent the cure for the very low cost op amps.

7. The Gain Cell: Linear Large-Scale Integration

As the true limitations of the basic op amp are more fully understood, this knowledge can be applied to the development of more "optimum" amplifiers. There are, of course, many ways in which one might choose to optimize the device. We might, for example, attempt to maximize speed (bandwidth, slew rate, settling time) without sacrificing dc characteristics. The compatible JFET/bipolar amp of *Figure 15* represents such an effort. An alternate choice might be to design an amplifier having all of the performance features of the most widely used general purpose op amps (i.e., μ A741, LM107, etc.), but having minimum possible die area. Such a pursuit is parallel to the efforts of digital large-scale integration (LSI) designers in their development of minimum



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FIGURE 27. Basic g_m reduction obtained by using split collector p-n-p's. C_c and area are reduced since $C_c = g_{m1}/\omega_u$.

area memory cells or gates. The object of such efforts, of course, is to develop lower cost devices which allow wide and highly economic usage.

In this section we briefly discuss certain aspects of the linear *gain cell*, a general purpose, internally compensated op amp having a die area which is significantly smaller than that of equivalent, present day, industry standard amplifiers.

A. Transconductance Reduction

The single largest area component in the internally compensated op amp is the compensation capacitor (about 30 pF, typically). A major interest in reducing amplifier die area, therefore, centers about finding ways in which this capacitor can be reduced in size. With this in mind, we find it useful to examine (15), which relates compensation capacitor size to two other parameters, unity gain corner frequency ω_U , and first stage transconductance g_{m1} . It is immediately apparent

that for a fixed, predetermined unity gain corner (about $2\pi \times 1$ MHz in our case), there is only one change that can be made to reduce the size of C_C : *the transconductance of the first stage must be reduced*. If we restrict our interest to simple bipolar input stages (for low cost), we recall the $g_{m1} = qI_1/kT$. Only by reducing I_1 can g_{m1} be reduced, and we earlier found in Section 6-A and Figure 19(a) and (b) that I_1 cannot be reduced much without causing phase margin difficulties due to the mirror pole and the tail pole.

An alternate basic approach to g_m reduction is illustrated in Figure 27 [12]. There, a multiple collector p-n-p structure, which is easily fabricated in IC form, is used to split the collector current into two components, one component (the larger) of which is simply tied to ground, thereby "throwing away" a major portion of the transistor output current. The result is that the g_m of the transistor is reduced by the ratio of $1/(1+n)$ (see Figure 27), and the compensation capaci-

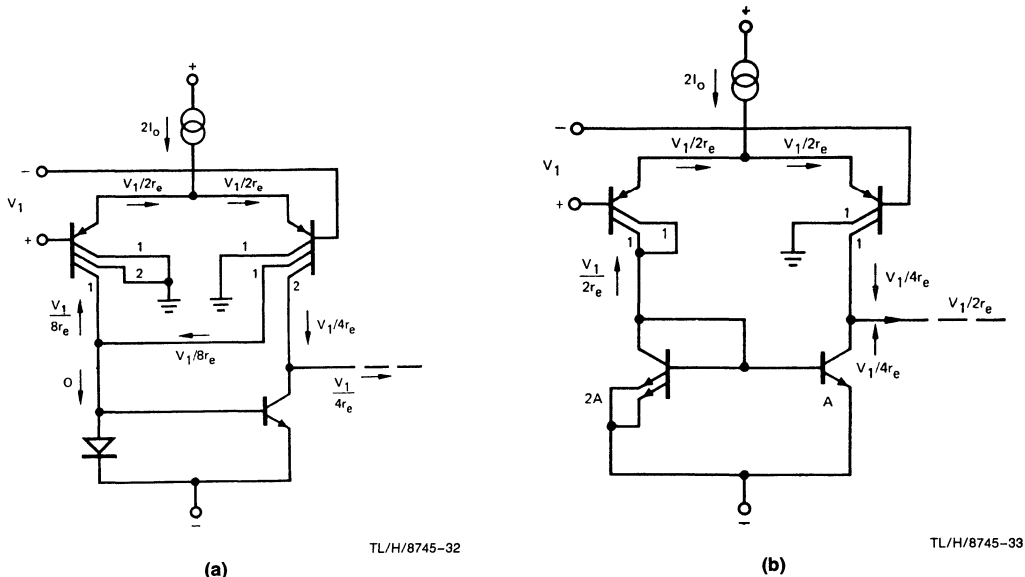


FIGURE 28. Variations on g_m reduction. (a) Cross-coupled connection eliminates all ac current passing through the mirror, yet maintains dc balance. (b) This approach maintains high current on the diode side of the mirror, thereby broadbanding the mirror pole.

tance can be reduced directly by the same factor. It might appear that the mirror pole would still cause difficulties since the current mirror becomes current starved in *Figure 27*, but the effect is not as severe as might be expected. The reason is that the inverting signal can now pass through the high current wide-band path, across the differential amp emitters and into the second stage, so at least half the signal current does not become bandlimited. This partial band-limiting can be further reduced by using one of the circuits in *Figure 28(a)* or *(b)*.⁴ In *(a)*, the p-n-p collectors are cross coupled in such a way that the ac signal is cancelled in the mirror circuit, while dc remains completely balanced. Thus the mirror pole is virtually eliminated. The circuit does have a drawback, however, in that the uncorrelated noise currents coming from the two p-n-p's add rather than subtract at the input to the mirror, thereby degrading noise performance. The circuit in *Figure 28(b)* does not have this defect, but requires care in matching p-n-p collector ratios to n-p-n emitter areas. Otherwise offset and drift will degrade as one attempts to reduce g_m by large factors.

B. A Gain Cell Example

As one tries to make large reductions in die area for the gain cell, many factors must be considered in addition to novel circuit approaches. Of great importance are special layout/circuit techniques which combine a maximum number of components into minimum area.

In a good layout, for example, all resistors are combined into islands with transistors. If this is not possible initially, circuit and device changes are made to allow it. The resulting device geometrics within the islands are further modified in shape to allow maximum "packing" of the islands. That is, when the layout is complete, the islands should have shapes which fit together as in a picture puzzle, with no waste of space. Further area reductions can be had by modifying the isolation process to one having minimum spacing between the isolation diffusion and adjacent p-regions.

As example of a gain cell which employs both circuit and layout optimization is shown in *Figure 29*: This circuit uses the g_m reduction technique of *Figure 28(a)* which results in a compensation capacitor size of only 5 pF rather than the normal 30 pF. The device achieves a full 1 MHz bandwidth, a 0.67V/ μ s slew rate, a gain greater than 100,000, typical offset voltages less than 1 mV, and other characteristics normally associated with an LM107 or μ A741. In quad form each amplifier requires an area of only 23 x 35 mils which is one-fourth the size of today's industry standard μ A741 (typically 56 x 56 mils). This allows over 8000 possible gain cells to be fabricated on a single 3-inch wafer. Further, it appears quite feasible to fabricate larger arrays of gain cells, with six or eight on a single chip. Only packaging and applications questions need be resolved before pursuing such a step.

⁴The circuit in *Figure 28(a)* is due to R. W. Russell and the variation in *Figure 28(b)* was developed by D. W. Zobel.

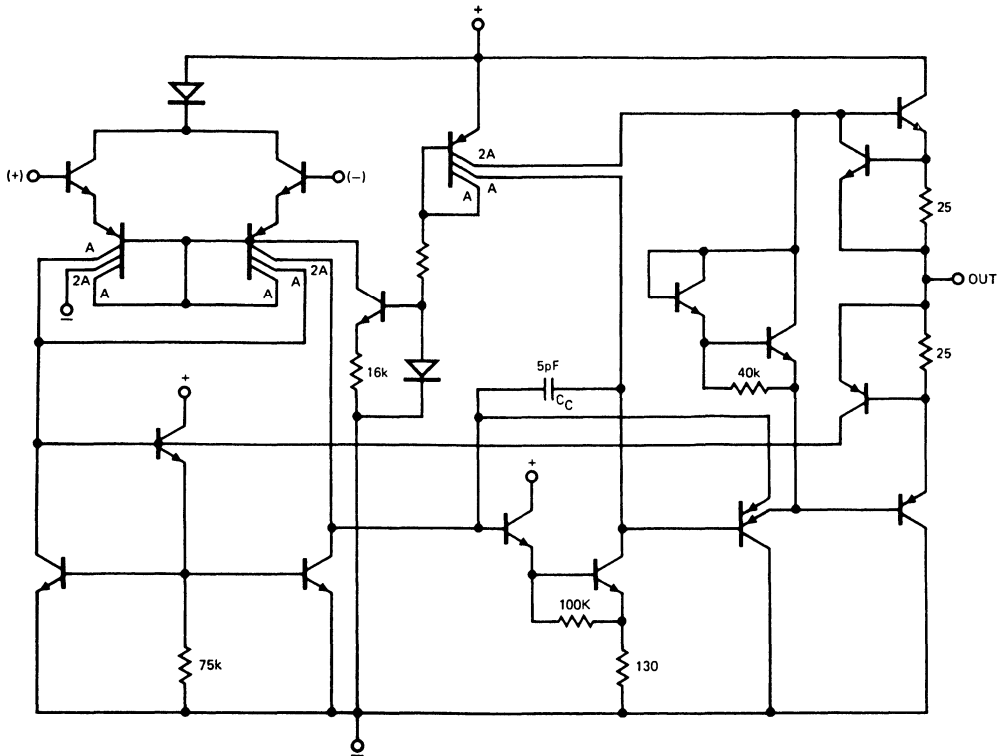


FIGURE 29. Circuit for optimized gain cell which has been fabricated in one-fourth the die size of the equivalent μ A741.

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ACKNOWLEDGMENT

Many important contributions were made in the gain cell and FET/bipolar op amp areas by R. W. Russell. The author gratefully acknowledges his very competent efforts.

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A Color TV Primer for the E. E.

National Semiconductor
Appendix B
Milt Wilcox



Section 1—The Color TV Receiver

Let's look at a color TV in terms of signal flow, from antenna to picture tube.

Although the frequencies used will be for the American NTSC system (National Television System Committee), the basic theory also applies to the European PAL system (Phase Alternating Line). Only in the chroma section do the two systems differ significantly.

RF AND IF SECTIONS

The first part is easy—all signal components received from the antenna pass through a tuner and IF amplifier to the video detector as shown in *Figure 1*.

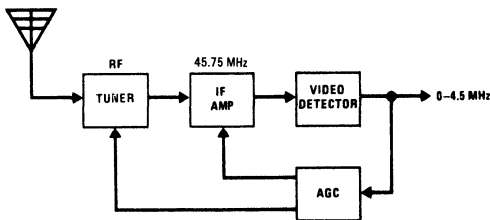


FIGURE 1

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The RF signal received ranges in frequency from 55 MHz for channel 2 up to 885 MHz (tuned with the aid of a UHF converter) for channel 83! The tuner has the job of amplifying the desired channel frequency and converting it to an intermediate frequency (IF) of 45.75 MHz. It is then further amplified in the IF amplifier.

The 45.75 MHz signal being amplified is called the video carrier. It is amplitude-modulated (AM) with the picture information, so the video detector must strip this information from the carrier by using some form of envelope detection. So far we could be describing a basic AM radio, except for the signal being received—instead of having audio at the detector output, we have video.

The output level from the video detector is usually around 3 Vp-p. This level must be produced by as little as 10 μ Vrms on the antenna, which works out to 110 dB conversion gain for the three blocks shown in *Figure 1*. However, the catch is the same TV may have to receive antenna signals of up to 0.5 Vrms, and still produce the same 3 Vp-p at the video detector. For this reason, a TV has a very effective automatic gain control (AGC) system which detects increases in the peak amplitude of the composite video signal and automatically reduces the gain of the tuner and IF amplifier to compensate.

SIGNAL INFORMATION

The picture you see on a color TV is actually formed by three electron beams, one each for red, blue and green being scanned horizontally and vertically over the screen. As these beams are scanned, their currents are changed to create the light and dark areas on the picture tube face which form the image you view. *Figure 2* shows the video detector output during the time that it takes the electron beams to make one horizontal scan across the screen. The output is actually a combination of four signal components which are required to form a color picture with sound. Let's look at them in turn:

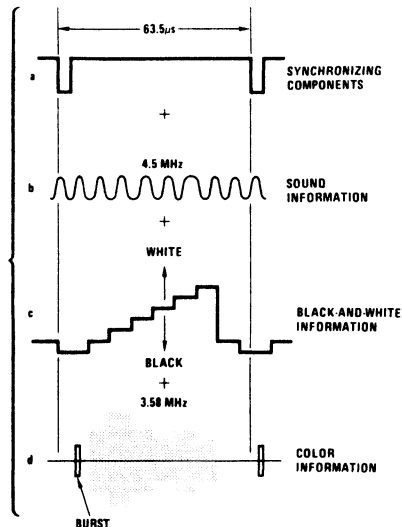
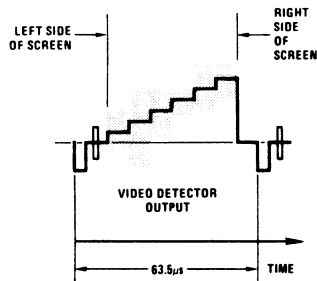


FIGURE 2

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a) Synchronizing Components

The synchronizing information is a series of pulses which tell the horizontal section when to return to the left of the screen to start a new *line*, and the vertical section when to return to the top of the screen to start a new *frame*. In the NTSC system each frame contains 525 lines. This is done by scanning the horizontal at approximately 15,750 lines per second, and the vertical at 30 frames per second (the vertical scan rate is actually 60 Hz, but it takes two trips down the screen to complete one frame). The process of returning to start a new scan is called retrace or flyback.

b) Sound Information

The sound information is carried in the form of frequency-modulation (FM) of a 4.5 MHz carrier which in turn modulates the video carrier. (That makes the 4.5 MHz a "sub-carrier"). This sub-carrier is very similar to the IF signal in an FM radio. Although the sound sub-carrier is available at the video detector, a separate detector is often used to reduce crosstalk between signal components.

c) Black-and-White Information (called luminance)

This information determines the instantaneous brightness of the electron beams as they are scanned over the screen. In fact, it is all that is used for the single electron beam in a black-and-white TV set. A negative going video detector detects a luminance signal in which the negative signal extremes correspond to dark areas of the picture and positive signal extremes correspond to bright areas of the picture. Thus the waveform shown in *Figure 2(c)* would produce vertical bars of increasing brightness from left to right. Note that the output is at black during retrace so the electron beams will not be seen. The luminance signal is designated by the letter Y.

d) Color Information (called chrominance)

The color information (which is ignored in a black-and-white TV) is made up of the red, blue and green signals required to drive the picture tube, *minus* the luminance signal. These "color difference" signals, designated R-Y, B-Y and G-Y, modulate a second subcarrier which has a frequency of 3.58 MHz.

Although the type of modulation used on the sub-carrier is of a complex nature it boils down to a simple result:

1. The instantaneous *phase* of the 3.58 MHz signal determines *what* color will be displayed (called hue or tint).
2. The instantaneous *amplitude* of the 3.58 MHz signal determines *how much* color will be displayed (called saturation).

An obvious question is, the phase and amplitude of the 3.58 MHz signal relative to what? The answer is a short burst of 3.58 MHz (simply called the *burst*) which has constant phase and amplitude. The burst will be used to determine the tint and saturation of the color to be displayed. For the waveform shown in *Figure 2(d)* each bar would have a different saturation.

The four signal components are separated and sent to their respective sections in the TV according to the type of signal. Since the sync pulses are the negative peaks of the composite video signal, a peak-detector circuit called a *sync-separator* is used to separate them. The sound and chroma information is contained in sub-carriers which are separated with 4.5 MHz and 3.58 MHz tuned-circuits respectively. The luminance information combines frequency components from 0-4 MHz and therefore uses wideband DC-coupling.

SIGNAL PROCESSING

The remaining sections of the Receiver will now be covered.

Scanning and High Voltage

The sync section is shown in *Figure 3*.

The sync pulses separated in the sync-separator are divided into vertical and horizontal components according to their pulse widths, the vertical sync pulse being a string of wide horizontal sync pulses. When these wide pulses are fed through an integrator, they average to form the vertical sync pulse. The vertical oscillator is "injection-locked" by the vertical sync pulse to initiate vertical retrace at the correct time. The output stage then delivers a ramp of current to the vertical deflection coils to produce vertical scan.

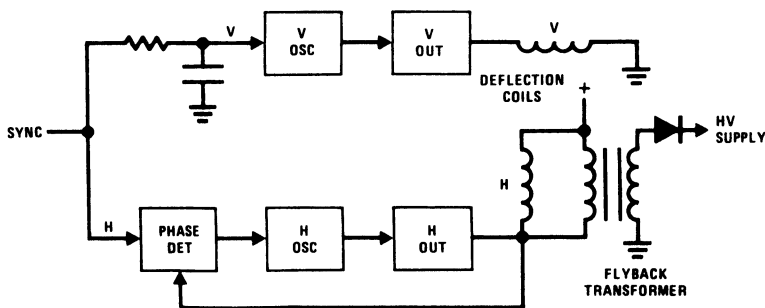


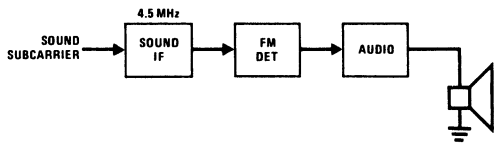
FIGURE 3

TL/H/8740-3

The horizontal section uses a different locking system, since horizontal retrace is started *before* the sync pulse is received in order to assure correct centering of the picture. This is done with a phase-locked loop (PLL) in which the oscillator is controlled by a phase detector to insure correct timing between the horizontal sync pulse and the flyback pulse produced by the output stage during horizontal retrace. The horizontal output stage does double duty—besides driving the horizontal deflection coils, it drives the flyback transformer for the picture tube anode high voltage supply. The 25–30 thousand volts DC required is generated either by directly rectifying or by tripling a hv flyback pulse derived from a large turns ratio on the flyback transformer.

The Sound Channel

The 4.5 MHz sound-subcarrier signal is amplified and limited in the sound IF to remove undesired amplitude information. The frequency modulation is then detected by an FM detector and applied to the audio amplifier.



TL/H/8740-4

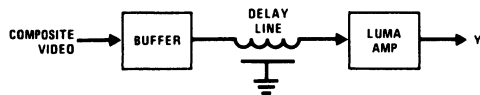
FIGURE 4

Limiting sensitivity for the sound section is typically $100 \mu\text{V}$ and the output power requirement is from 1W to 4W depending on receiver size.

Luma Processing

The luminance signal Y must be amplified and delayed some $0.8 \mu\text{s}$ on its way to the picture tube as shown in Figure 5. The delay is required to insure that the black and white information does not arrive at the picture tube before the color information, which is delayed by the comparatively narrow bandwidth of the 3.58 MHz chroma section.

The contrast and brightness controls are also located in the luminance amplifier. The *contrast* control changes the *peak-to-peak* amplitude of the signal, while the *brightness* control changes the *DC* level of the signal.



TL/H/8740-5

FIGURE 5

Chroma Processing

From the signal taken off the 3.58 MHz tuned circuit the chroma section must derive two signals:

1. The 3.58 MHz chroma sub-carrier signal of the correct amplitude and
2. A continuous 3.58 MHz chroma reference signal of the correct phase relative to the burst.

These two signals, when applied to the chroma demodulator, will produce the desired color difference signals R-Y, B-Y and G-Y. The chroma section is shown in Figure 6.

The first problem is that even though the AGC system holds the peak-to-peak video level constant, the chroma sub-carrier itself can vary in amplitude with transmission, antenna and fine-tuning changes, to name a few. Therefore, the chroma section requires an AGC loop of its own, which is called the Automatic Chroma Control stage, or ACC. This block compares the amplitude of the burst to a reference to keep the chroma output signal constant over a 20 dB input range.

The chroma signal is then gated into two components by a pulse derived from the horizontal section. The chroma sub-carrier (during horizontal scan) is sent to the chroma amplifier in which a gain control varies the saturation of the color picture. If *no* burst was present in the ACC stage, the output of the amplifier is "killed" completely for black and white reception.

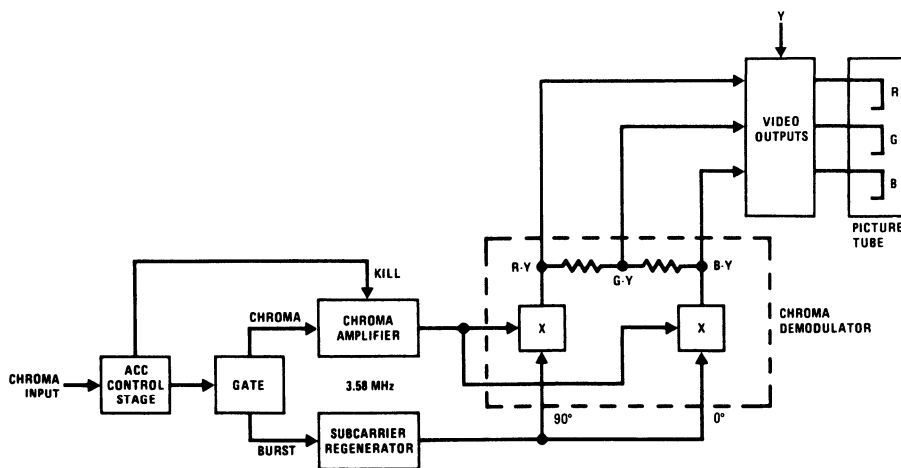


FIGURE 6

TL/H/8740-6

The burst (during horizontal retrace) is sent to the sub-carrier regenerator. This is actually a fancy name for a crystal-controlled 3.58 MHz oscillator which is locked to the frequency and phase of the incoming burst by either an injection-lock or phase-lock technique. This forms the reference output, which is passed through a variable phase-shift network to vary the tint of the color picture.

The outputs of the chroma amplifier and sub-carrier regenerator are the signals required by the chroma demodulator, which consists of two synchronous detectors operated in quadrature. What this means is that the reference phase applied to the B-Y detector makes it responsive only to chroma input phases corresponding to blue. The reference applied to the R-Y detector, which is 90° out of phase with the B-Y detector, makes it responsive only to red. The G-Y signal is derived by combining the R-Y and B-Y outputs in the correct ratios.

Finally, the luminance signal Y is added to the chroma difference signals R-Y, B-Y and G-Y to arrive at the desired red, blue and green signals. These signals are further amplified to 100 Vp-p in the video output stage and applied to the appropriate cathodes of the picture tube.

CONVERGENCE

One other messy, but needed function remains in a color TV receiver—color convergence. The need for convergence results from the origination of the three electron beams in different locations and the fact that they are being scanned over a flat, instead of round, surface. Therefore, the deflection of each beam must be modified separately such that it lands in the same location as the other beams over the entire face of the picture tube.

A complete block diagram of the color TV receiver is shown for reference in *Figure 7*.

Section 2—Integrated Circuits in Television

Here we will look at the integrated circuits used in television including a glimpse inside TV ICs.

Every area of the television which does not have too high a frequency or voltage requirement has been integrated at least once, and many are on second and third generation IC's. The only areas that have been "off-limits" to date are the tuner, video outputs, and horizontal/HV output sections.

RF AND IF SECTIONS

Monolithic circuits have been made to work very well at 45 MHz. The first IC IF systems used 2 chips: one for a 2-stage gain-controlled IF amplifier (Motorola MC1349, 52) and the second for a video detector with gain (Motorola MC1330). The major obstacle to combining these two chips into a single chip has been stability problems due to internal and/or external coupling output to input. However a one chip IF amplifier and video detector is now widely used in Europe (Telefunken TDA 440). The AGC system is also often included in these chips. Another IF function used in most color TV receivers today is automatic fine tuning (AFT) which keeps the tuner correctly tuned to the IF frequency (LM3064 type).

The first chip to incorporate all of the above functions into a single chip is the National LM1807. The chip uses a phase-locked loop to tune the tuner to the IF frequency set by a local oscillator on the chip. This concept is new to TV and is generating a lot of interest.

Rapid progress is also being made in periphery circuits to tuners. Present IC tuning systems control the voltage on a varactor in the tuner to tune the desired channel. However, new systems will actually "synthesize" the tuner local oscillator frequency for each channel.

SCANNING

The deflection area is one of the last to be integrated. While only low-level horizontal circuits have been integrated, vertical drivers and even output stages have been attempted. Current IC's include the Motorola MC1391 or Philips TBA 920 for horizontal and the SGS TDS 1270 for vertical.

In the standard U.S. television system, the vertical and horizontal scanning frequencies are related by the formula $f_v = 2f_h/525$. The National DM8890 makes use of this fact by dividing down a horizontal signal to generate vertical timing, thus eliminating the need for a vertical hold control. Although previous combined vertical/horizontal chips have been unsuccessful, the digital approach holds much promise and TI has announced a combined chip using I²L.

THE SOUND CHANNEL

The LM3065 type sound IF/FM Detector is currently used in most TV receivers along with a class B discrete or IC audio amplifier. However, virtually every IC manufacturer has announced a one chip "sound system" combining the IF, detector, and audio amplifier. National's entry is the LM1808 which has been well received.

LUMA PROCESSING

Standard IC's have not been developed for the Luma area because of questionable economics. Instead, most of the efforts so far have been custom, with different IC's being used by Zenith, Sylvania, and several European TV companies.

CHROMA PROCESSING

The first IC in TV was the chroma demodulator. Today every color TV has one, usually an LM746 or LM1828 type. In one variation the luminance signal is added to the color difference outputs on the chip (Motorola MC1324).

The chroma amplifier and subcarrier regenerator sections have been integrated using a phase-locked loop system with two chips (LM3070 and LM3071 types) and an injection-locked system with one chip (Motorola MC1398). Both of these systems are widely used. Second generation systems which do the phase-locked system with one chip (RCA CA3126 or Motorola MC1399) are gaining acceptance. All of these systems can be used with the above-mentioned demodulators.

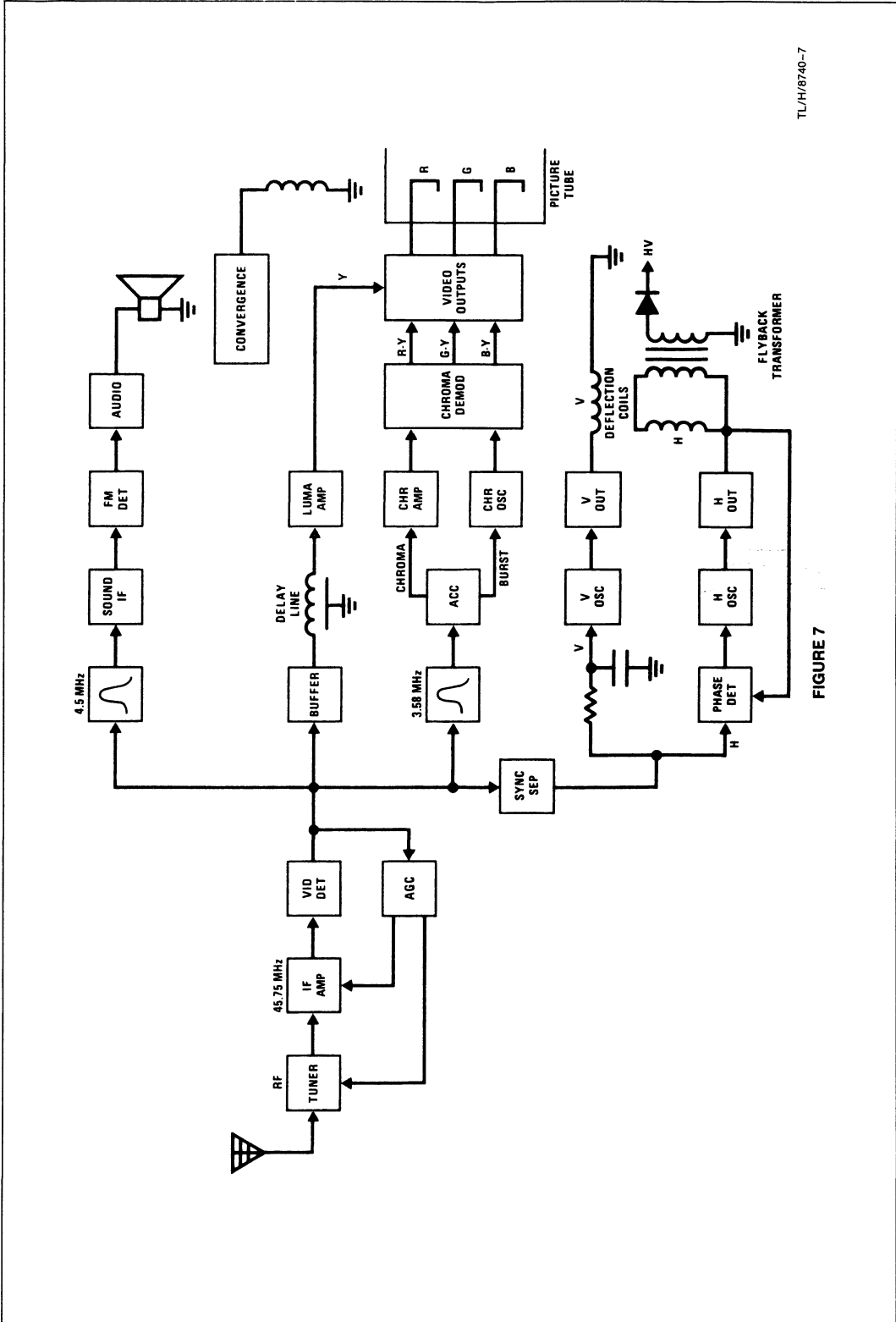
Thus, so far the chroma section takes a minimum of two chips, including the demodulator. When will the demodulator be combined with the rest of the system for a true one-chip chroma? Hitachi has just introduced the first practical attempt and others are sure to follow.

WHAT'S A JUNGLE?

A "jungle" IC is a combination of miscellaneous TV functions on one chip. For example, the Zenith jungle (LM1845 type) does the sync-separator and AGC functions. The term is also sometimes applied to deflection IC's which include other functions.

INSIDE TV IC's

Next to the basic differential amplifier, the most widely used linear circuits in TV IC's are probably the current-sharing gain control stage and the linear multiplier.



TL/H/8740-7

FIGURE 7

GAIN CONTROL

The current-sharing gain control stage is so named because the input current is shared between two outputs depending on the DC control voltage V_C . For the circuit shown in *Figure 8*, the small signal gain at room temperature is given by:

$$A = \frac{\Delta V_{OUT}}{\Delta V_{IN}} \cong \frac{R_L/R_o}{1 + \exp\left(\frac{V_C \text{ in mV}}{26}\right)}$$

As V_C is increased, the circuit acts as a logarithmic attenuator, yielding a gain reduction of approximately 20 dB for each 60 mV of applied voltage. This same basic gain control stage is used in IF AGC and chroma ACC circuits, as well as for volume, contrast, and chroma controls.

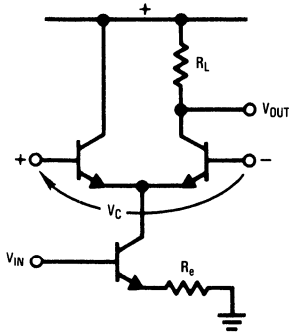


FIGURE 8

TL/H/8740-8

MULTIPLIER

The multiplier is widely used in television IC's for amplitude, phase, and frequency detection. *Figure 9* shows a typical configuration in which the bottom pair is degenerated for linear operation while the top quad is switched. If $V_a(t)$ is an amplitude modulated carrier $F_m(t)\cos \omega t$ and $v_b(t)$ is a square wave of the same frequency ω and relative phase ϕ , then the filtered output is given by:

$$V_{OUT} \cong \frac{2}{\pi} \frac{R_L}{R_o} F_m(t) \cos \phi$$

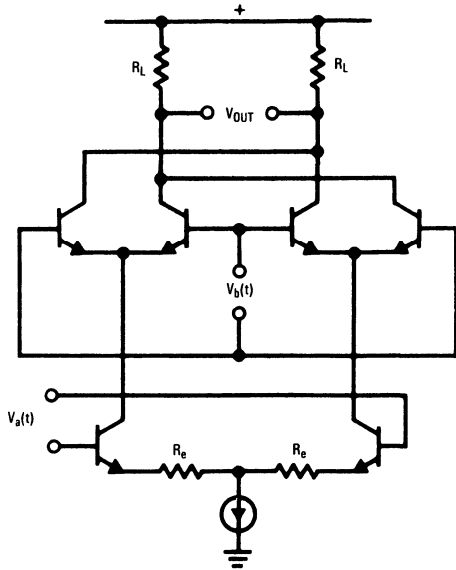


FIGURE 9

TL/H/8740-9

Thus the output depends on the amplitude of V_a and the relative phase ϕ between V_a and V_b .

If ϕ is made 0° so $\text{COS } \phi$ is 1, then the multiplier acts as an amplitude detector and can be used to detect the video modulation on the IF carrier. Note that around 0° $\text{COS } \phi$ changes very little with phase. To use the multiplier as a phase or frequency detector, $V_a(t)$ is limited to remove amplitude information and ϕ is centered at 90° where $\text{COS } \phi$ produces the largest change in output for a given change in phase. This operation mode is used for chroma burst phase detectors and sound FM detectors. Both the amplitude and phase sensitive properties of the multiplier are used in chroma demodulators.

V/F Converter ICs Handle Frequency-to-Voltage Needs

National Semiconductor
Appendix C
Robert A. Pease



Simplify your F/V converter designs with versatile V/F ICs. Starting with a basic converter circuit, you can modify it to meet almost any application requirement. You can spare yourself some hard labor when designing frequency-to-voltage (F/V) converters by using a voltage-to-frequency IC in your designs. These ICs form the basis of a series of accurate, yet economical, F/V converters suiting a variety of applications.

Figure 1 shows an LM331 IC (or LM131 for the military temperature range) in a basic F/V converter configuration (sometimes termed a stand-alone converter because it requires no op amps or other active devices other than the IC). (Comparable V/F ICs, such as RM4151, can take advantage of this and other circuits described in this article, although they might not always be pin-for-pin compatible).

This circuit accepts a pulse-train or square wave input amplitude of 3V or greater. The 470 pF coupling capacitor suits negative-going input pulses between 80 μ s and 1.5 μ s, as well as accommodating square waves or positive-going pulses (so long as the interval between pulses is at least 10 μ s).

IC Handles the Hard Part

The LM331 detects an input-signal change by sensing when pin 6 goes negative relative to the threshold voltage at pin 7, which is nominally biased 2V lower than the supply voltage. When a signal change occurs, the LM331's input comparator sets an internal latch and initiates a timing cycle. During this cycle, a current equal to V_{REF}/R_S flows out of pin 1 for

a time $t = 1.1 R_C C$. The 1 μ F capacitor filters this pulsating current from pin 1, and the current's average value flows through load resistor R_L . As a result, for a 10 kHz input, the circuit outputs 10 V_{DC} across R_L with good (0.06% typical) nonlinearity.

Two problems remain, however: the output at V1 includes about 13 mVp-p ripple, and it also lags 0.1 second behind an input frequency step change, settling to 0.1% of full-scale in about 0.6 second. This ripple and slow response represent an inherent tradeoff that applies to almost every F/V converter.

The Art of Compromise

Increasing the filter capacitor's value reduces ripple but also increases response time. Conversely, lowering the filter capacitor's value improves response time at the expense of larger ripple. In some cases, adding an active filter results in faster response and less ripple for high input frequencies.

Although the circuit specifies a 15V power supply, you can use any regulated supply between 4 V_{DC} and 40 V_{DC} . The output voltage can extend to within 3 V_{DC} of the supply voltage, so choose R_L to maintain that output range.

Adding a 220 k Ω /0.1 μ F postfilter to the circuit slows the response slightly, but it also reduces ripple to less than 1 mVp-p for frequencies from 200 Hz to 10 kHz. The reduction in ripple achieved by adding this passive filter, while not as good as that obtainable using an active filter, could suffice in some applications.

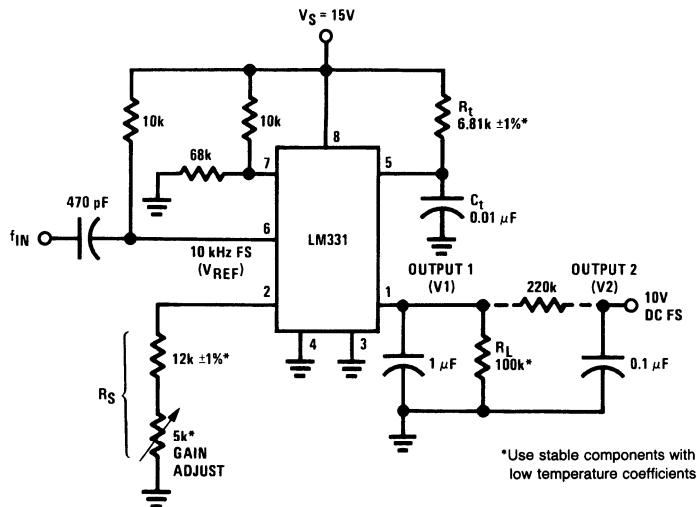


FIGURE 1. A Simple Stand-Alone F/V Converter Forms the Basis for Many Other Converter-Circuit Configurations

TL/H/8741-1

Improving the Basic Circuit

Further modifications and additions to the basic F/V converter shown in *Figure 1* can adapt it to specific performance requirements. *Figure 2* shows one such modification, which improves the converter's nonlinearity to 0.006% typical.

Reconsideration of the basic stand-alone converter shows why its nonlinearity falls short of this improved version's. At low input frequencies, the current source feeding pin 1 in the LM331 is turned off most of the time. As the input frequency increases, however, the current source stays on more of the time, and its own impedance attenuates the output signal for an increasing fraction of each cycle time. This disproportionate attenuation at higher frequencies causes a parabolic change in full-scale gain rather than the desired linear one.

In the improved circuit, on the other hand, the PNP transistor acts as a cascade, so the output impedance at pin 1 sees a constant voltage that won't modulate the gain. Also, with an alpha ranging between 0.998 and 0.999, the transistor exhibits a temperature coefficient of between 10 ppm/°C and 40 ppm/°C—a fairly minor effect. Thus, this circuit's

nonlinearity does not exceed 0.01% maximum for the 10V output range shown and is normally not worse than 0.01% for any supply voltage between 4V and 40V.

Add an Output Buffer

The circuit in *Figure 3* adds an output buffer (unity-gain follower) to the basic single-supply F/V converter. Either an LM324 or LM358 op amp functions well in a single-supply circuit because these devices' common-mode ranges extend down to ground. But if a negative supply is available, you can use any op amp; types such as the LF351B or LM308A, which have low input currents, provide the best accuracy.

The output buffer in *Figure 3* also acts as an active filter, furnishing a 2-pole response from a single op amp. This filter provides the general response

$$V_{OUT}/I_{OUT} = R_L / (1 + K1p + K2p^2)$$

(p is the differential operator d/dt.) As shown, R_L controls the filter's DC gain. The high frequency response rolls off at 12 dB/octave. Near the circuit's natural resonant frequency, you can choose the damping to give a little overshoot—or none, as desired.

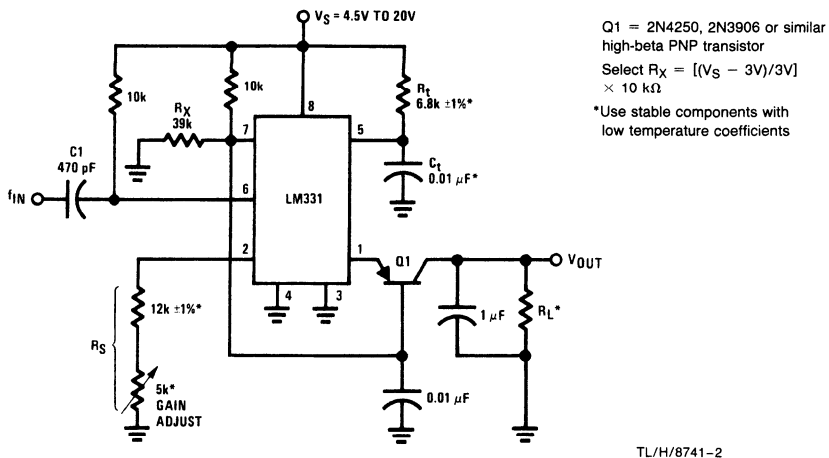


FIGURE 2. Adding a Cascade Transistor to the LM331's Output Improves Nonlinearity to 0.006%

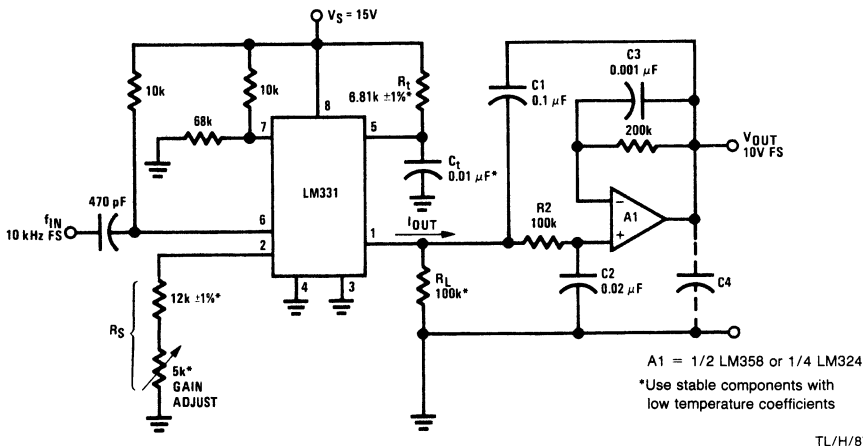


FIGURE 3. The Op Amp on This F/V Converter's Output Acts as a Buffer as Well as a 2-Pole Filter

Dealing with F/V Converter Ripple

Voltage ripple on the output of F/V converters can present a problem, and the chart shown in *Figure A* indicates exactly how big a problem it is. A simple, slow, RC filter exhibits low ripple at all frequencies. Two-pole filters offer the lowest ripple at high frequencies and provide a 30-times-faster step response than RC devices.

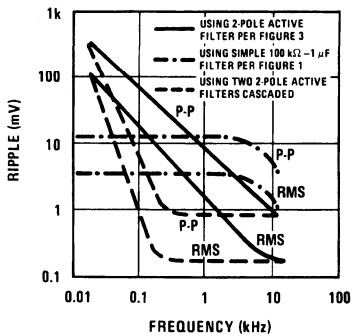
To reduce a circuit's ripple at moderate frequencies, however, you can cascade a second active-filter stage on the F/V converter's output. That circuit's response also appears in *Figure A* and shows a significant improvement in low-ripple bandwidth over the single-active-filter configuration, with only a 30% degradation of step response.

Figures B and C show filter circuits suitable for cascading. The inverting filter in *Figure B* requires closely matched resistors with a low TC over their temperature range for best accuracy. For lowest DC error, choose $R_5 = R_2 + (R_{IN}|R_F)$. This circuit's response is

$$-V_{OUT}/V_{IN} = n/(1 + (R_F + R_2 + nR_2)C_4p + R_F R_2 C_3 C_4 p^2)$$

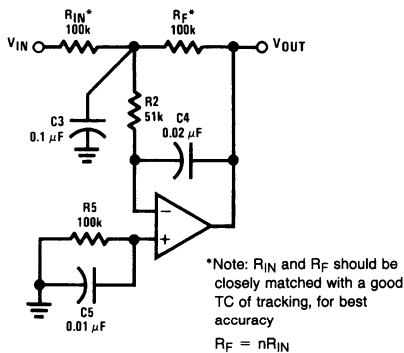
where $n =$ DC gain. If $R_{IN} = R_F$ and $n = 1$,

$$-V_{OUT}/V_{IN} = 1/(1 + (R_F + 2R_2)C_4p + R_F R_2 C_3 C_4 p^2)$$



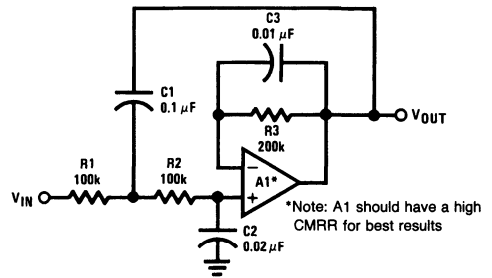
TL/H/8741-4

FIGURE A. Output-Ripple Performance of Several Different F/V Converter Configurations Illustrates the Effect of Voltage Ripple



TL/H/8741-5

FIGURE B. You Can Cascade This 2-Pole Inverting Filter onto an F/V Converter's Output



TL/H/8741-6

FIGURE C. This 2-Pole Noninverting Filter Suits Cascade Requirements on F/V Converter Outputs

The circuit shown in *Figure C* does not require precision passive components, but for best accuracy, choosing an A1 with a high CMRR is critical. An LM308A op amp's 96 dB minimum CMRR suits this circuit well, but an LM358B's 85 dB typical figure also proves adequate for many applications. Circuit response is

$$V_{OUT}/V_{IN} = 1/(1 + (R_1 + R_2)C_2p + R_1 R_2 C_1 C_2 p^2)$$

For best results, choose $R_3 = R_1 + R_2$.

Components Determine Response

The specific response of the circuit in *Figure 3* is

$$V_{OUT}/I_{OUT} = R_L/(1 + (R_L + R_2)C_2p + R_L R_2 C_1 C_2 p^2)$$

Making C_2 relatively large eliminates overshoot and sine peaking. Alternatively, making C_2 a suitable fraction of C_1 (as is done in *Figure 3*) produces both a sine response with 0 dB to 1 dB of peaking and a quick real-time response having only 10% to 30% overshoot for a step response. By maintaining *Figure 3's* ratio of $C_1:C_2$ and $R_2:R_L$, you can adapt its 2-pole filter to a wide frequency range without tedious computations.

This filter settles to within 1% of a 5V step's final value in about 20 ms. By contrast, the circuit with the simple RC filter shown in *Figure 1* takes about 900 ms to achieve the same response, yet offers no less ripple than *Figure 3's* op amp approach.

As for the other component in the 2-pole filter, any capacitance between 100 pF and 0.05 μ F suits C_3 because it serves only as a bypass for the 200 k Ω resistor. C_4 helps reduce output ripple in single positive power-supply systems when V_{OUT} approaches so close to ground that the op amp's output impedance suffers. In this circuit, using a tantalum capacitor of between 0.1 μ F and 2.2 μ F for C_4 usually helps keep the filter's output much quieter without degrading the op amp's stability.

Avoid Low-Leakage Limitations

Note that in most ordinary applications, this 2-pole filter performs as well with 0.1 μF and 0.02 μF capacitors as the passive filter in *Figure 1* does with 1 μF . Thus, if you require a 100 Hz F/V converter, the circuit in *Figure 3* furnishes good filtering with $C_1 = 10 \mu\text{F}$ and $C_2 = 2 \mu\text{F}$, and eliminates the 100 μF low-leakage capacitor needed in a passive filter.

Note also that because C_1 always has zero DC voltage across it, you can use a tantalum or aluminum electrolytic capacitor for C_1 with no leakage-related problems; C_2 , however, must be a low-leakage type. At room temperature, typical 1 μF tantalum components allow only a few nanoamperes of leakage, but leakage this low usually cannot be guaranteed.

Compensating for Temperature Coefficients

F/V converters often encounter temperature-related problems usually resulting from the temperature coefficients of passive components. Following some simple design and manufacturing guidelines can help immunize your circuits against loss of accuracy when the temperature changes.

Capacitors fabricated from Teflon or polystyrene usually exhibit a TC of $-110 \pm 30 \text{ ppm}/^\circ\text{C}$. When you use such a component for the timing capacitor in an F/V converter (such as C_t in the *figure*) the circuit's output voltage—or the gain in terms of volts per kilohertz—also exhibits a $-110 \text{ ppm}/^\circ\text{C}$ TC.

But the resistor-diode network (R_X , D_1 , D_2) connected from pin 2 to ground in the *figure* can cancel the effect of the timing capacitor's large TC. When $R_X = 240 \text{ k}\Omega$, the current flowing through pin 1 will then have an overall TC of 110 $\text{ppm}/^\circ\text{C}$, effectively canceling a polystyrene timing capacitor's TC to a first approximation. Thus, you needn't find a zero-TC capacitor for C_t , so long as its temperature coefficient is stable and well established. As an additional advantage, the resistor-diode network nearly compensates to zero the TC of the rest of the circuit.

Bake it for a While

After the circuit has been built and checked out at room temperature, a brief oven test will indicate the sign and the size of the TC for the complete F/V converter. Then you can add resistance in series with R_X , or add conductance in

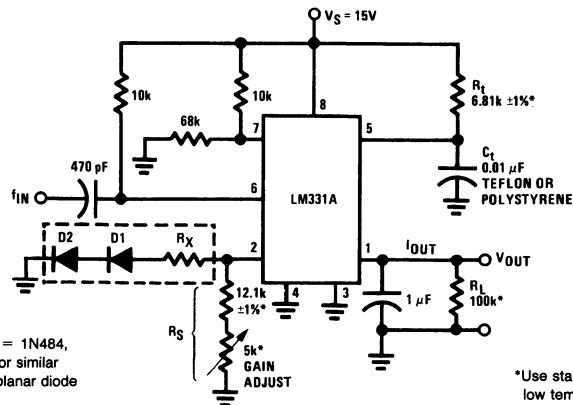
parallel with it, to greatly diminish the TC previously observed and yield a complete circuit with a lower TC than you could obtain simply by buying low TC parts.

For example, if the circuit increases its full-scale output by 0.1% per 30°C (33 $\text{ppm}/^\circ\text{C}$) during the oven test, adding 120 $\text{k}\Omega$ in series with $R_X = 240 \text{ k}\Omega$ cancels the temperature-caused deviation. Or, if the full-scale output decreases by -0.04% per 20°C ($-20 \text{ ppm}/^\circ\text{C}$), just add 1.2 $\text{M}\Omega$ in parallel with R_X .

Note that to allow trimming in both directions, you must start with a finite *fixed* TC (such as the $-110 \text{ ppm}/^\circ\text{C}$ of C_t), which then nominally cancels out by the addition of a finite *adjustable* TC. Only by using this procedure can you compensate for whatever polarity of TC is found by the oven test.

You can utilize this technique to obtain TCs as low as 20 $\text{ppm}/^\circ\text{C}$, or perhaps even 10 $\text{ppm}/^\circ\text{C}$, if you take a few passes to zero-in on the best value for R_X . For optimum results, consider the following guidelines:

- Use a good capacitor for C_t ; the cheapest polystyrene capacitors can shift value by 0.05% or more per temperature cycle. In that case, you would not be able to distinguish the actual temperature sensitivity from the hysteresis, and you would also never achieve a stable circuit.
- After soldering, bake or temperature-cycle the circuit (at a temperature not exceeding 75°C in the case of polystyrene) for a few hours to stabilize all components and to relieve the strains of soldering.
- Do not rush the trimming. Recheck the room temperature value before *and* after you take the high temperature data to ensure a reasonably low hysteresis per cycle.
- Do not expect a perfect TC at -25°C if you trim for $\pm 5 \text{ ppm}/^\circ\text{C}$ at temperatures from $+25^\circ\text{C}$ to 60°C . None of the components in the *figure's* circuit offer linearity much better than 5 $\text{ppm}/^\circ\text{C}$ or 10 $\text{ppm}/^\circ\text{C}$ cold, if trimmed for a zero TC at warm temperatures. Even so, using these techniques you can obtain a data converter with better than 0.02% accuracy and 0.003% linearity, for a $\pm 20^\circ\text{C}$ range around room temperature.
- Start out the trimming with R_X installed and its value near the design-center value (e.g., 240 $\text{k}\Omega$ or 270 $\text{k}\Omega$), so you



D1, D2 = 1N484,
FD333 or similar
silicon planar diode

*Use stable components with
low temperature coefficients

TL/H/8741-7

Two Diodes and a Resistor Help Decrease an F/V Converter's Temperature Coefficient

will be reasonably close to zero TC; you will usually find the process slower if you start without any resistor, because the trimming converges more slowly.

- If you change R_X from 240 k Ω to 220 k Ω , do not pull out the 240 k Ω part and put in a new 220 k Ω resistor—you will get much more consistent results by adding a 2.4 M Ω resistor in parallel. The same admonition holds true for adding resistance in series with R_X .
- Use reasonably stable components. If you use an LM331A (± 50 ppm/ $^{\circ}$ C maximum) and RN55D film resistors (each ± 100 ppm/ $^{\circ}$ C) for R_L , R_t and R_S , you probably won't be able to trim out the resulting ± 350 ppm/ $^{\circ}$ C worst-case TC. Resistors with a TC specification of 25 ppm/ $^{\circ}$ C usually work well. Finally, use the same resistor value (e.g., 12.1 k Ω $\pm 1\%$) for both R_S and R_t ; when these resistors come from the same manufacturer's batch, their TC tracking will usually rate at better than 20 ppm/ $^{\circ}$ C.

Whenever an op amp is used as a buffer (as in *Figure 3*), its offset voltage and current (± 7.5 mV maximum and ± 100 nA, respectively, for most inexpensive devices) can cause a ± 17.5 mV worst-case output offset. If both plus and minus supplies are available, however, you can easily provide a symmetrical offset adjustment. With only one supply, you can add a small positive current to each op amp input and also trim one of the inputs.

Need a Negative Output?

If your F/V converter application requires a negative output voltage, the circuit shown in *Figure 4* provides a solution with excellent linearity ($\pm 0.003\%$ typical, $\pm 0.01\%$ maximum). And because pin 1 of the LM331 always remains at 0 V_{DC} , this circuit needs no cascade transistor. (Note, howev-

er, that while the circuit's nonlinearity error is negligible, its ripple is not.)

The circuit in *Figure 4* offers a significant advantage over some other designs because the offset adjust voltage derives from the stable 1.9 V_{DC} reference voltage at pin 2 of the LM331; thus any supply voltage shifts cause no output shifts. The offset pot can have any value between 200 k Ω and 2 M Ω .

An optional bypass capacitor (C_2) connected from the op amp's positive input to ground prevents output noise arising from stray noise pickup at that point; the capacitance value is not critical.

A Familiar Response

The circuit in *Figure 4* exhibits the same 2-pole response—with heavy output ripple attenuation—as the noninverting filter in *Figure 3*. Specifically,

$$V_{OUT}/I_{OUT} = R_F / (1 + (R_4 + R_F)C_4p + R_4R_F C_3 C_4 p^2)$$

Here also, $R_5 = R_4 + R_F = 200$ k Ω provides the best bias current compensation.

The LM331 can handle frequencies up to 100 kHz by utilizing smaller-value capacitors as shown in *Figure 5*. This circuit increases the current at pin 2 to facilitate high-speed switching, but, despite these speed-ups, the LM331's 500 ppm/ $^{\circ}$ C TC at 100 kHz causes problems because of switching speed shifts resulting from temperature changes.

To compensate for the device's positive TC, the LM334 temperature sensor feeds pin 2 a current that decreases linearly with temperature and provides a low overall temperature coefficient. An R_V value of 30 k Ω provides first-order compensation, but you can trim it higher or lower if you need more precise TC correction.

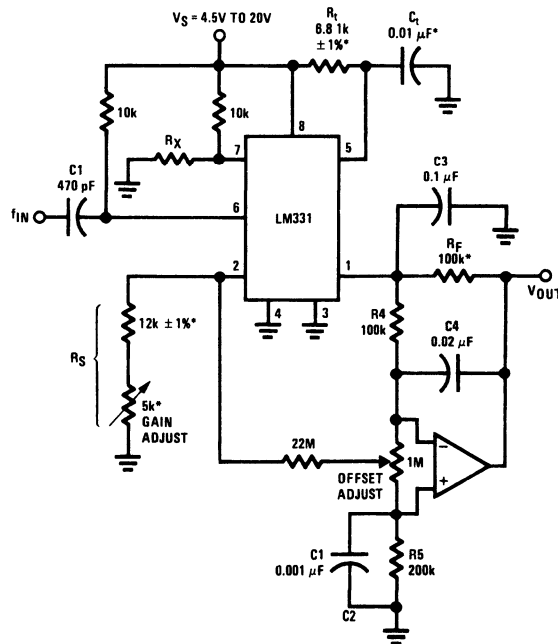


FIGURE 4. In This F/V Circuit, the Output-Buffer Op Amp Derives Its Offset Voltage from the Precision Voltage Source at Pin 2 of the LM331

TL/H/8741-8

Detect Frequencies Accurately

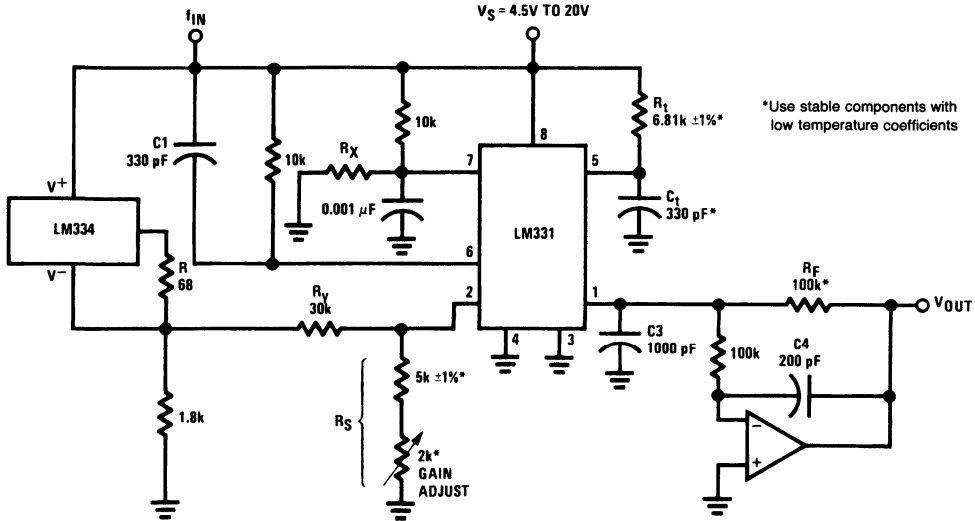
Using an F/V converter combined with a comparator as a frequency detector is an obvious application for these devices. But when the F/V converter is utilized in this way, its output ripple hampers accurate frequency detection, and the slow filter frequency response causes delays.

If a quick response is not important, though, you can effectively utilize an LM331-based F/V converter to feed one or more comparators, as shown in Figure 6. For an input frequency drop from 1.1 kHz to 0.5 kHz, the converter's output

responds within about 20 ms. When the input falls from 9 kHz to 0.9 kHz, however, the output responds only after a 600 ms lag, so utilize this circuit only in applications that can tolerate F/V circuits' inherent delays and ripples.

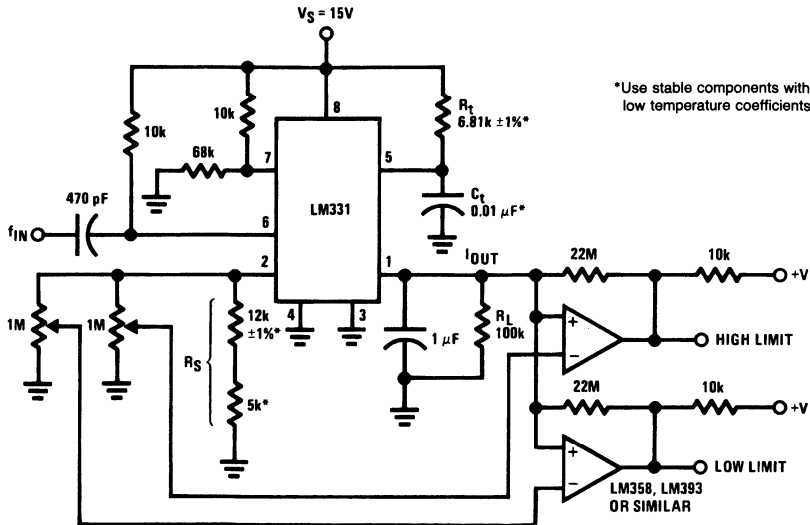
Author's Biography

Bob Pease is a staff scientist in the Advanced Linear Integrated Circuit Group at National Semiconductor Corp., Santa Clara, CA. Holder of four patents, he earned a BSEE from MIT. Bob lists tracking abandoned railroad roadbeds and designing V/F converters as hobbies.



TL/H/8741-9

FIGURE 5. An LM334 Temperature Sensor Compensates for the F/V Circuit's Temperature Coefficient



TL/H/8741-10

FIGURE 6. Combining a V/F IC with Two Comparators Produces a Slow-Response Frequency Detector

Versatile Monolithic V/Fs Can Compute as Well as Convert with High Accuracy

National Semiconductor
Appendix D
Robert A. Pease



The best of the monolithic voltage-to-frequency (V/F) converters have performance that's so good it equals or exceeds that of modular types. Some of these ICs can be designed into quite a variety of circuits because they're notably versatile. Along with versatility and high performance come the advantages that are characteristic of all V/F converters, including good linearity, excellent resolution, wide dynamic range, and an output signal that's easy to transmit as well as couple through an isolator.

One of the recently introduced monolithic types, the LM131, has both high performance and a design that's rather flexible. For instance, it can compute and convert at the same time; the computation is a part of the conversion. Among other functions, it can provide the product, ratio and square root of analog inputs.

This IC has an internal reference for its conversion circuitry that's also brought out to a pin, so it's available to external circuits associated with the converter. Not surprisingly, it turns out that any deviations of the reference, due to process variations and temperature changes have equal and opposite effects on the scale factors of the converter and the external circuitry. (This presumes, of course, that the scale factor of the external circuitry is a linear function of voltage.)

PRECISION RELAXATION OSCILLATOR

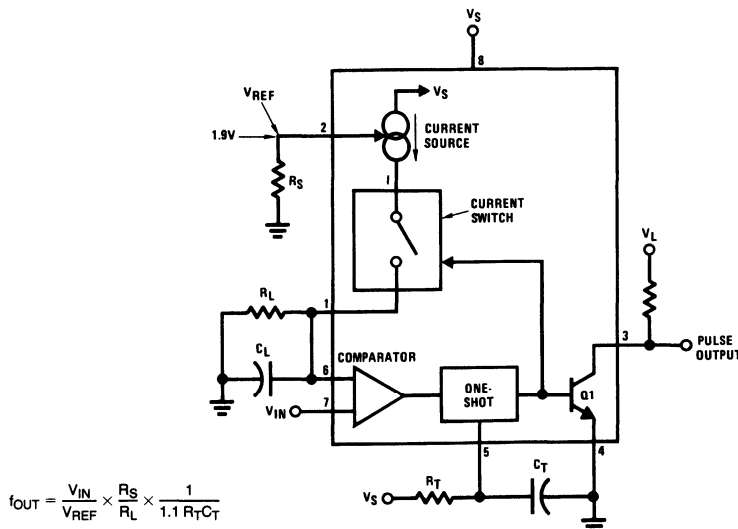
Before looking at some applications, quickly take a look at the basic circuit of an LM131 V/F converter (*Figure 1*). Basically, this IC, like any V/F converter, is a precision relaxation oscillator that generates a frequency linearly proportional to

the input voltage. As might be expected, the circuit has a capacitor, C_L , with a sawtooth voltage on it. Generally speaking, the circuit is a feedback loop that keeps this capacitor charged to a voltage very slightly higher than the input voltage, V_{IN} . If V_{IN} is high, C_L discharges relatively quickly through R_L , and the circuit generates a high frequency. If V_{IN} is low, C_L discharges slowly, and the converter puts out a low frequency.

When C_L discharges to a voltage equal to the input, the comparator triggers the one-shot. The one-shot closes the current switch and also turns on the output transistor. With the switch closed, current from the current source recharges C_L to a voltage somewhat higher than the input. Charging continues for a period determined by R_T and C_T . At the end of this period, the one-shot returns to its quiescent state and C_L resumes discharging.

Resistor R_S sets the amount of current put out by the current source. In fact, the current in pin 1, with the switch on, is identical to the current in pin 2. The latter pin is at a constant voltage (nominally 1.90V), so a given resistor value can set the operating currents. When connected to a high impedance buffer, this pin provides a stable reference for external circuits.

The open-collector output at pin 3 permits the output swing to be different from the converter's supply voltage, if the load circuit requires. The supplies don't have to be separate, however, and both the converter and its load can use the same voltage.

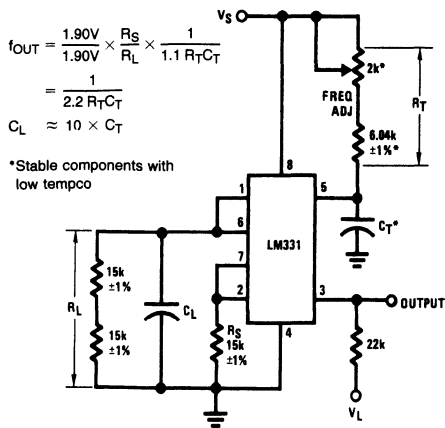


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FIGURE 1. A voltage-to-frequency converter such as this is a relaxation oscillator with a frequency proportional to the input voltage. Current pulses keep C_L 's average voltage slightly greater than the input voltage.

STEADY AS SHE GOES

By far the simplest of the circuits that make use of the reference output voltage from the LM131 is one that simply ties this output pin right back to the signal input. This connection is just a V/F converter with a constant input, which makes it a constant-frequency oscillator. Even with this simple circuit (Figure 2), variations in the reference voltage have two opposite effects that cancel each other out, so the circuit is particularly stable. In this type of circuit, the temperature-dependent internal delays tend to cancel as well, which isn't true of relaxation oscillators based on op amps or comparators.

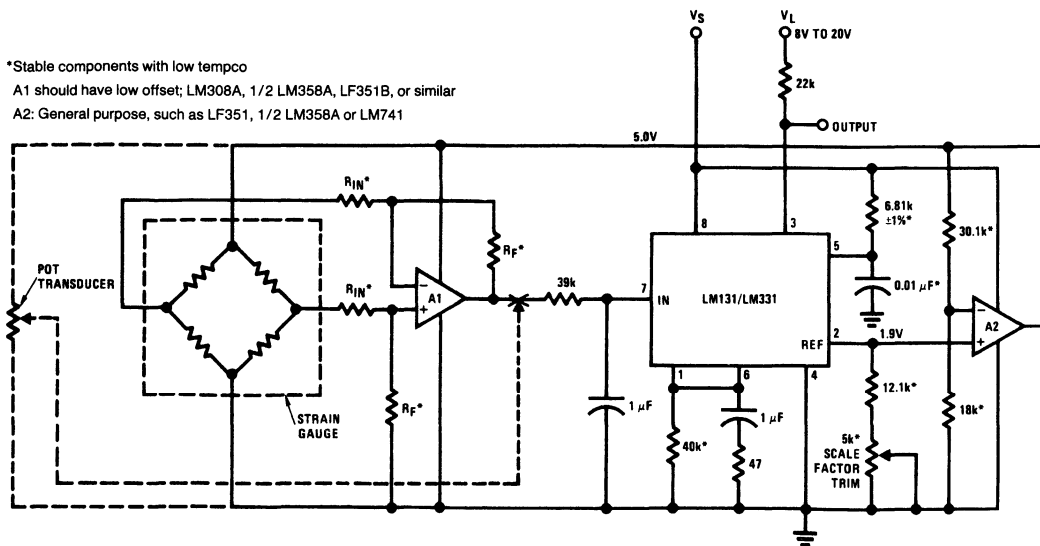


TL/H/8742-2

FIGURE 2. A V/F converter is a stable-frequency oscillator if its input is connected to its reference output. If the reference voltage changes, the effects of the change cancel out, so the frequency doesn't change. With low tempco components for R_T and C_T , frequency stability vs temperature can be as good as ± 25 ppm/ $^{\circ}$ C.

*Stable components with low tempco

A1 should have low offset; LM308A, 1/2 LM358A, LF351B, or similar
A2: General purpose, such as LF351, 1/2 LM358A or LM741



TL/H/8742-3

FIGURE 3. In this strain-to-frequency converter, the converter's reference excites the strain gauge (or the optional pot) through buffer amp A2. This makes the circuit insensitive to changes in the reference voltage.

Resistors R_L and R_S are best taken from the same batch. (R_L must be larger than R_S , so it's made up of two resistors.) By doing this, the tempo tracking, which is the critical parameter, is five to ten times better than it would be if R_L were a single 30.1 k Ω resistor.

Although the reference output, pin 2, can't be loaded without affecting the converter's sensitivity, the comparator input, pin 7, has a high impedance so this connection does no harm.

Frequency stability is typically ± 25 ppm/ $^{\circ}$ C, even with an LM331, which as a V/F converter is specified only to 150 ppm/ $^{\circ}$ C maximum. From 20 Hz to 20 kHz, stability is excellent, and the circuit can generate frequencies up to 120 kHz.

Although the simplest way of using the reference output is to tie it back to the input, the reference can also be buffered and amplified to supply such external circuitry as a resistive transducer, which might be a strain gauge or a pot (Figure 3). As in the stable oscillator already described, deviations of the internal reference voltage from the ideal cause the transducer's and the converter's sensitivities to change equally in opposite directions, so the effects cancel.

In this circuit, op amp A2 buffers and amplifies the constant voltage at pin 2 of the converter to provide the 5V excitation for the strain gauge. Amplifier A1, connected as an instrumentation amplifier, raises the output of the strain gauge to a usable level while rejecting common-mode pickup.

A potentiometer-type transducer works just as well with this circuit. Its wiper output takes the place of A1's output as shown at the X.

The reference terminal is both a constant voltage output and a current programming input. So far, it's been shown simply with one or two resistors going to ground. It is, however, a full-fledged signal input that accepts a signal from a current source quite well.

This extra input is what enables the LM131 to compute while converting. For instance, it will convert the ratio of two voltages to a frequency proportional to the ratio (Figure 4). The circuit is still a V/F converter, but has two signal inputs, both of them going to rather unorthodox places at that. The inputs, shown as voltages, are converted to currents by two current pumps (voltage-to-current converters). Of course, if currents of the proper ranges are available, the current pumps aren't needed. The left current pump, which includes Q1 and A1, determines how fast capacitor C_L discharges between output pulses. The other pump sets the current in the reference circuit to control the amount of recharge current when the one-shot fires. Tying the comparator input, pin 7, to the reference pin sets the comparator's trip point at a constant voltage.

*Stable components with low tempo

A1, A2 should have low offset and low bias current: LM351B, LM358A, LF353B, or similar
Q1, Q2: 2N3565, 2N2484, or similar high β

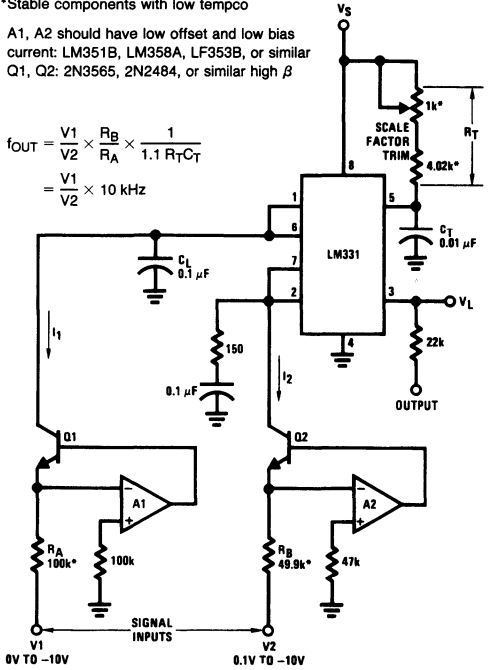
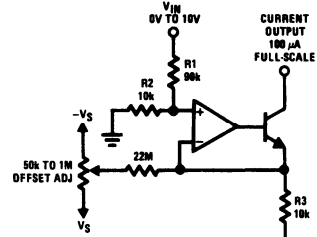


FIGURE 4. This circuit converts the ratio of two voltages to an equivalent frequency without a separate analog divider. Full-scale output is 15 kHz. The two op amp circuits convert the inputs to proportional currents.

To get an idea of how the circuit works, consider first the effect of, for instance, tripling the input voltage, V_1 . This makes C_L discharge to the comparator trip point three times as fast, so the frequency triples. Next, consider a given change, such as doubling the voltage at the other input, V_2 . This doubles the recharge current to C_L during the fixed-width output pulse, which means C_L 's voltage increases twice as much during recharging. Since the discharge into Q1 is linear (for V_1 constant), it takes twice as long for C_L to discharge—the frequency becomes half of what it was before.

Although the current pumps in Figure 4 must have negative inputs, rearranging the op amp according to Figure 5 makes them accept positive inputs instead. Trimming out the offset in the op amp gives the ratio converter better

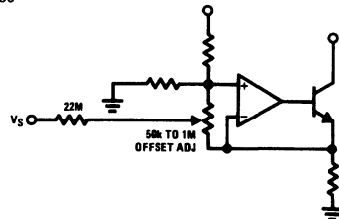
linearity and accuracy. The trim circuit in Figure 5a needs stable positive and negative supplies for the offset trimmer, while the one in Figure 5b needs only a stable positive supply. Unmarked components in Figure 5b are the same as in Figure 5a.



a

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R1, R2, R3: Stable components with low tempo
Q1: $\beta \geq 330$



b

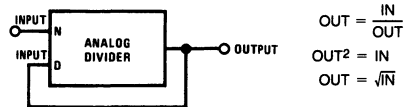
TL/H/8742-6

FIGURE 5. These current pumps adapt the converter circuits in Figures 4 and 6 to positive input voltages. Optional offset trimming improves linearity and accuracy, especially with input signals that have a wide dynamic range.

Note that the full-scale range of the current pumps can be changed by varying the value of the input resistor(s). If either of these pump circuits is used with a single positive supply, the op amp should be a type such as 1/2 LM358 or 1/4 LM324, which has a common-mode range that includes the negative-supply bus.

COMPUTING SQUARE ROOTS IMPLICITLY

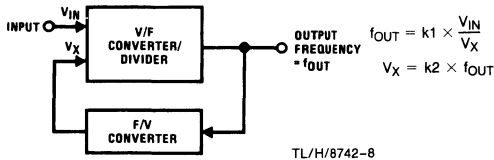
An analog divider computes the square root of a signal when the signal is fed to the divider's numerator input, and the output is fed back to the divider's denominator input.



TL/H/8742-7

This type of computation is called implicit, because the end result of the computation is only implied, not explicitly stated by the equation that defines the computation.

In the implicit square root computing loop described in the text, a V/F converter serves as a divider. Since it's a converter, its inputs are voltages (or currents), but its output is a frequency. To connect its output back to one of its inputs so it will compute a square root means that its output frequency must be converted back to a voltage. This is taken care of by the frequency-to-voltage converter.



Doing some algebraic substitution shows that:

$$f_{OUT} = k3 \times \sqrt{V_{IN}}$$

where

$$k3 = \sqrt{k1/k2}.$$

IT'LL TAKE RECIPROCALLS

Taking the ratio of two inputs—in other words, doing division—is only one of the mathematical operations that can be combined with converting. Another one is a special case of division, which is taking reciprocals. In this instance, the numerator (V_1 in *Figure 4*) is held constant, and the denominator, V_2 , changes over a wide range such as one or two decades. In this case, since the frequency is the reciprocal of the input, the period of the output is proportional to the input. When operated this way, the V_2 current pump should have an offset trimmer. A constant current circuit is still needed to discharge capacitor C_L .

Nonlinearity (that is, deviation from the ideal law) with an LM331 is a little better than 1% for 10 kHz full-scale. Increasing C_T to 0.1 μF reduces the nonlinearity to below 0.2% while decreasing full-scale output to 1 kHz.

Two inputs can also be multiplied while converting to a frequency. The multiplying converter circuit (*Figure 6*) that

does this has a more elaborate current pump than the ratio circuit of *Figure 4*. This pump is really two cascaded circuits; it includes op amps A2 and A3 as well as transistors Q2 and Q3. Current from this pump goes to pin 5 to control the one-shot's pulse width. (This current ranges from 13.3 μA to 1.33 mA.)

As in the ratio circuit, the left current pump controls the discharge rate of C_L . The other pump, however, controls the one-shot's pulse width to vary the amount that C_L charges during the pulse. If the V_2 input is close to zero, the current from the pump into pin 5 is small, and the one-shot develops a wide pulse. This allows C_L to charge quite a bit. It takes a relatively long time for C_L to discharge to the comparator threshold, so the resulting frequency is low. As V_2 goes negative (a greater absolute magnitude), the output frequency rises. Op amp A3 must have a common-mode range that extends to the positive supply voltage, which the specified types do.

Multiplying, dividing and converting can all be done at the same time by combining the V_2 input current pump of *Figure 4* with the circuit of *Figure 6*. If a scale-factor trimmer is needed, R4 in *Figure 6* is a good choice, better than input resistors such as R1 or R2. Using the latter as trimmers would make the input impedance of the circuit change with trim setting.

Two V/F converter ICs along with some extra circuitry will take the square root of a voltage input. Square root functions are used mostly to simulate natural laws, but also to linearize functions that have a natural square-law relationship. One of the latter is converting differential pressure to flow, where flow is proportional to the square root of differential pressure.

*Stable components with low tempco

$$f_{OUT} = \frac{V_1}{10V} \times \frac{V_2}{10V} \times 10 \text{ kHz}$$

$V_S = 15V$, regulated and stable

$$R3 = \left(\frac{15.00V}{+V_S} \right) \times 750\Omega \text{ with } \pm 1\% \text{ tolerance}$$

A1, A2: Each is 1/2 LM158/LM358A or 1/2 LF353B

A3: LM301A, LM307, or LF13741 only

Q1, Q2: High β such as 2N2484, 2N3565 or similar

Q3: High β such as 2N4250, 2N3906 or similar

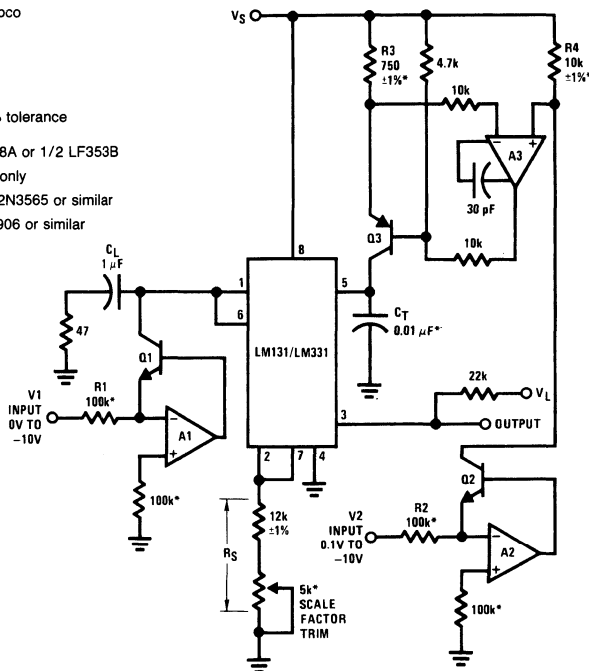


FIGURE 6. The product of two input voltages becomes an equivalent frequency in this converter. A current pump that includes op amps A2 and A3 controls the pulse duration of the converter's internal one-shot.

VERSATILE PIN FUNCTIONS GIVE DESIGN FLEXIBILITY

Two features—the reference and the one-shot—of the LM131/LM331 V/F converter deserve a closer look because they are the key to its versatility. The simplified schematic of the chip, shown here along with a transducer and the components needed for a basic V/F converter, will help to illustrate how these features work.

The reference circuit, connected to pin 2, is both a constant voltage output and a current setting, scale-factor control input. The constant voltage can supply external circuitry, such as the transducer, that feeds the converter's input.

One great advantage of using the converter's internal reference to supply the external circuitry is that any variation in the reference voltage affects the sensitivities of the converter and the external circuitry by equal and opposite amounts, so the effects of the variation cancel.

While providing a constant voltage output, pin 2 also provides scale-factor, or sensitivity control for the converter. Current supplied to an external circuit by this terminal comes from the supply (V_S) through the current mirror and the transistor. The op amp drives this transistor to hold pin 2 at a constant voltage equal to the internal reference, which is nominally 1.9V.

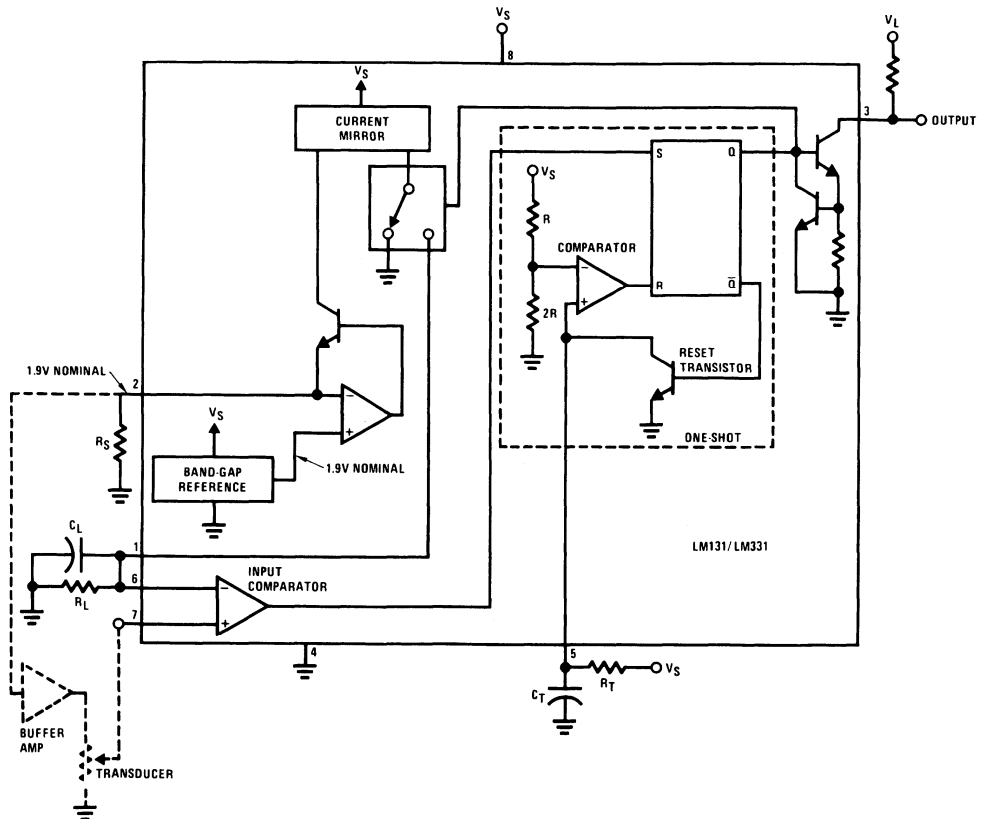
The current mirror provides a current to the switch that's essentially identical to that in pin 2. This means that a

resistor to ground or a signal from a current source will set the current that is switched to pin 1. In most circuits, a capacitor goes from pin 1 to ground, and the switched current from this pin recharges the capacitor during the pulse from the one-shot.

The one-shot circuit is somewhat like the well known 555 timer's circuit. In the quiescent state, the reset transistor is on and holds pin 5 near ground. When pin 7 becomes more positive than pin 6 (or pin 6 falls below pin 7), the input comparator sets the flip-flop in the one-shot.

The flip-flop turns on the current limited output transistor (pin 3) and switches the current coming from the current mirror to pin 1. The flip-flop also turns off the reset transistor, and the timing capacitor C_T starts to charge toward V_S . This charge is exponential, and C_T 's voltage reaches 2/3 of V_S in about 1.1 $R_T C_T$ time constants. (The quantity 1.1 is $-\ln 0.333\dots$) When pin 5 reaches this voltage, the one-shot's comparator resets the flip-flop which turns off the current to pin 1, discharges C_T , and turns off the output transistor.

If the voltages at pins 6 and 7 still call for setting the flip-flop after pin 5 has reached 2/3 V_S , internal logic not shown in this simplified diagram overrides the reset signal from the one-shot's own comparator, and the flip-flop stays set. In this instance, C_T continues charging past 2/3 V_S .



ROOT LOOP COMPUTES

The circuit in *Figure 7* is an implicit loop (see "Computing Square Roots Implicitly") that uses IC1 as a voltage-to-frequency converter and divider, and IC2 as a frequency-to-voltage converter. The F/V converter, IC2, and the current pump that includes A1 and the transistor return the output of IC1 to its denominator input. A relatively elaborate feedback circuit like this is needed to convert IC1's frequency output back to a current for its denominator input.

Looking at the circuit in more detail, IC1 puts out a frequency proportional to V_{IN} divided by the feedback voltage, V_X . The current I_1 is generated by a current pump that has V_X as its input (*Figure 5a*). To develop the feedback IC2 converts the pulse output from IC1 into standard width precision current pulses that charge capacitor C1. This capacitor integrates them into the voltage V_X , thus closing the loop.

Op amp A2, serving as a comparator, ensures that the circuit will always start and continue running. If V_{IN} suddenly jumps to a higher voltage, one pulse from the one-shot in IC1 may not be enough to recharge C_1 to a voltage higher than the input. In such a case, the IC's internal logic keeps its internal current switch turned on, and the voltage on C_1 ramps up until it exceeds the input. During this time, however, IC1's output hasn't changed state. (Such a temporary hang-up isn't unique to this circuit, and equivalent things happen to other V/Fs besides the LM131/LM331.) What is worse here, though, is that the lack of pulses to IC2 means that V_X and I_1 decay. The recharging current, I_2 , is the same as I_1 , so it not only becomes progressively harder for the voltage on C_1 to catch up with the input, it may even fail to catch up entirely if $(I_2 \times R_L)$ is less than the input voltage.

As a sign of this condition, when the converter hangs up, the one-shot's timing node, pin 5, continues to charge well beyond its normal peak of $2/3 V_S$. As soon as the comparator A2 detects this rise, it pulls up voltage V_X , current I_1 increases, and the loop catches its breath again.

After all these nonlinear computations, this last circuit is about as linear as it can be. It's a precision, ultralinear V/F converter based on an LM331A (*Figure 8*) that has several detail refinements over previous V/F converter circuits. Choosing the proper components and trimming the tempco give less than 0.02% error and 0.003% nonlinearity for a $\pm 20^\circ\text{C}$ range around room temperature.

This circuit has an active integrator, which includes the op amp and the integrating feedback capacitor, C_F . The integrator converts the input voltage, which is negative, into a positive-going ramp. When the ramp reaches the converter IC's comparator threshold, the one-shot fires and switches a pulse of current to the integrator's summing junction. This current makes the integrator's output ramp down quickly. When the one-shot times out, the cycle repeats.

There are several reasons this converter circuit gives high performance:

- A feedback limiter prevents the op amp from driving pin 7 of the LM331A negative. The limiter circuit arrangement bypasses the leakage through CR5 to ground via R5, so it won't reach the summing junction. Bypassing leakage this way is especially important at high temperatures.
- The offset trimming pot is connected to the stable 1.9V reference at pin 2 instead of to a power supply bus that might be unstable and noisy.

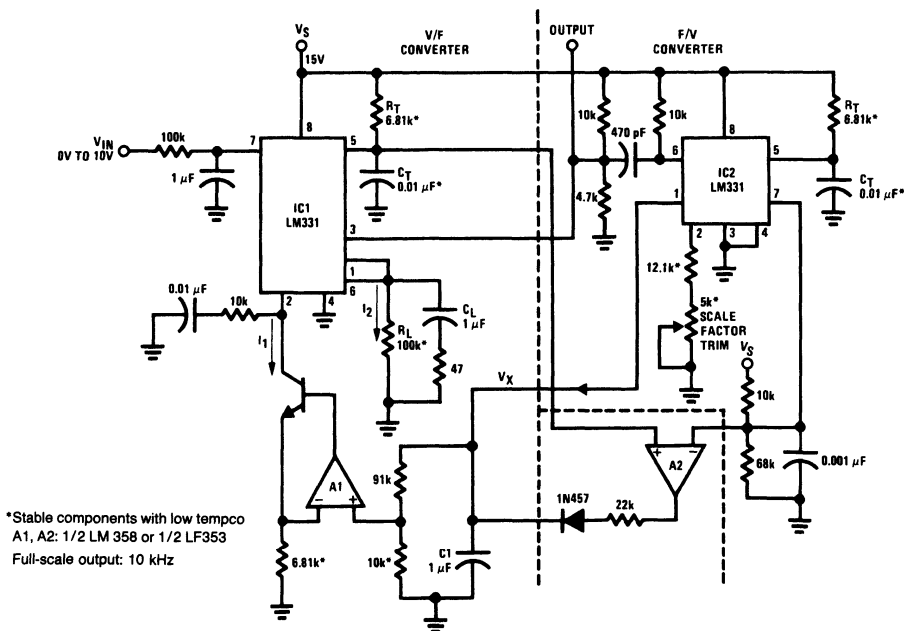
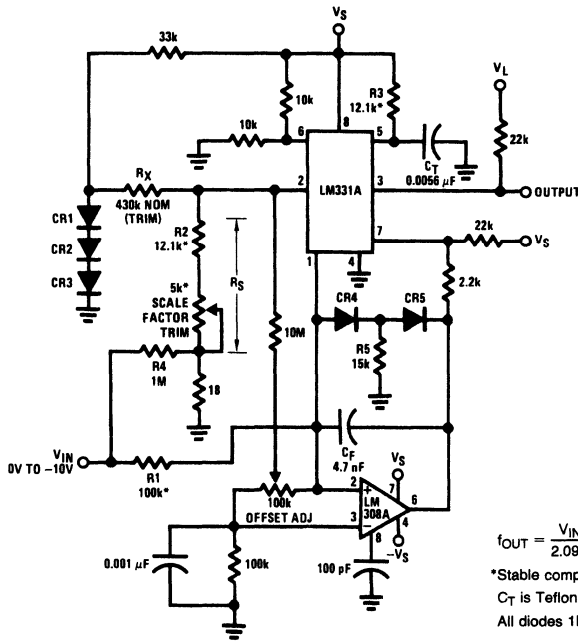


FIGURE 7. Two converter ICs generate an output frequency proportional to the square root of the input voltage. The circuit is an implicit loop in which IC1 serves as a divider and V/F converter. This IC's output goes back to its denominator input through F/V converter IC2 to make the circuit output equal the input's square root.

TL/H/8742-11



$$f_{OUT} = \frac{V_{IN}}{2.09V} \times \frac{R_S}{R_1} \times \frac{1}{R_3 C_T} \quad \text{Full-scale output 10 kHz}$$

*Stable components with low tempco; see text

C_T is Teflon or Polystyrene

All diodes 1N457, 1N484, or FD333 (low-leakage silicon)

TL/H/8742-12

FIGURE 8. An ultraprecision V/F converter, capable of better than 0.02% error and 0.003% nonlinearity for a $\pm 20^\circ\text{C}$ range about room temperature, augments the basic converter with an external integrator.

- A small fraction (180 μV , full-scale) of the input voltage goes via R4 to the R_S network, which improves the non-linearity from 0.004% to 0.002%.
- Resistors R2 and R3 are the same value, so that resistors such as Allen-Bradley type CC metal-film types can provide excellent tempco tracking at low cost. (This tracking is very good when equal values come from the same batch.) Resistor R1 should be a low tempco metal-film or wirewound type, with a maximum tempco of ± 10 ppm/ $^\circ\text{C}$ or ± 25 ppm/ $^\circ\text{C}$.

In addition, C_T should be a polystyrene or Teflon type. Polystyrene is rated to 80°C , while Teflon goes to 150°C . Both types can be obtained with a tempco of -110 ± 30 ppm/ $^\circ\text{C}$. Choosing this tempco for C_T makes the tempco, due to C_T , of the full-scale output frequency 110 ppm/ $^\circ\text{C}$.

Using tight tolerance components results in a total tempco between 0 ppm/ $^\circ\text{C}$ and 220 ppm/ $^\circ\text{C}$, so the tempco will never be negative. The voltage at CR1 and R_X has a tempco of -6 mV/ $^\circ\text{C}$, which can be used to compensate the tempco of the rest of the circuit. Trimming R_X compensates for the tempco of the V/F IC, the capacitor, and all the resistors.

A good starting value for selecting R_X is 430 k Ω , which will give the 135 μA flowing out of pin 2 a slope of 110 ppm/ $^\circ\text{C}$. If the output frequency increases with temperature, a little more conductance should be added in parallel with R_X .

When doing a second round of trimming, though, note that a resistor of, say, 4.3 M Ω , has about the same effect on tempco when shunted across a 220 k Ω resistor that it does when shunted across one of 430 k Ω , namely, -11 ppm/ $^\circ\text{C}$. This technique can give tempcos below ± 20 ppm/ $^\circ\text{C}$ or even ± 10 ppm/ $^\circ\text{C}$.

Some precautions help this procedure converge:

1. Use a good capacitor for C_T . The cheapest polystyrene capacitors will shift in value by 0.05% or more per temperature cycle. The actual temperature sensitivity would be indistinguishable from the hysteresis, and the circuit would never be stable.
2. After soldering, bake and/or temperature-cycle the circuit (at a temperature not exceeding 75°C if C_T is polystyrene) for a few hours, to stabilize all components and to relieve the strains from soldering.
3. Don't rush the trimming. Recheck the room temperature value, before and after the high temperature data are taken, to ensure that hysteresis per cycle is reasonably low.
4. Don't expect a perfect tempco at -25°C if the circuit is trimmed for ± 5 ppm/ $^\circ\text{C}$ between 25°C and 60°C . If it's been trimmed for zero tempco while warm, none of its components will be linear to much better than 5 ppm/ $^\circ\text{C}$ or 10 ppm/ $^\circ\text{C}$ when it's cold.

The values shown in this circuit are generally optimum for $\pm 12\text{V}$ to $\pm 16\text{V}$ regulated supplies but any stable supplies between $\pm 4\text{V}$ and $\pm 22\text{V}$ would be usable, after changing a few component values.

APPENDIX E: Standard Resistance Values

The standard 1% (and 1/2%) resistor values are recommended for ease of design and for best availability when designing precision analog circuits.

Standard Resistance Values for the 10-to-100 Decade

Resistance Tolerance (+ %)																	
0.1			0.1			0.1			0.1			0.1			0.1		
0.25	1	2	0.25	1	2	0.25	1	2	0.25	1	2	0.25	1	2	0.25	1	2
0.5	5	5	0.5	5	5	0.5	5	5	0.5	5	5	0.5	5	5	0.5	5	5
10.0	10.0	10	14.7	14.7	—	21.5	21.5	—	31.6	31.6	—	46.4	46.4	—	68.1	68.1	68
10.1	—	—	14.9	—	—	21.8	—	—	32.0	—	—	47.0	—	47	69.0	—	—
10.2	10.2	—	15.0	15.0	15	22.1	22.1	22	32.4	32.4	—	47.5	47.5	—	69.8	69.8	—
10.4	—	—	15.2	—	—	22.3	—	—	32.8	—	—	48.1	—	—	70.6	—	—
10.5	10.5	—	15.4	15.4	—	22.6	22.6	—	33.2	33.2	33	48.7	48.7	—	71.5	71.5	—
10.6	—	—	15.6	—	—	22.9	—	—	33.6	—	—	49.3	—	—	72.3	—	—
10.7	10.7	—	15.8	15.8	—	23.2	23.2	—	34.0	34.0	—	49.9	49.9	—	73.2	73.2	—
10.9	—	—	16.0	—	16	23.4	—	—	34.4	—	—	50.5	—	—	74.1	—	—
11.0	11.0	11	16.2	16.2	—	23.7	23.7	—	34.8	34.8	—	51.1	51.1	51	75.0	75.0	75
11.1	—	—	16.4	—	—	24.0	—	24	35.2	—	—	51.7	—	—	75.9	—	—
11.3	11.3	—	16.5	16.5	—	24.3	24.3	—	35.7	35.7	—	52.3	52.3	—	76.8	76.8	—
11.4	—	—	16.7	—	—	24.6	—	—	36.1	—	36	53.0	—	—	77.7	—	—
11.5	11.5	—	16.9	16.9	—	24.9	24.9	—	36.5	36.5	—	53.6	53.6	—	78.7	78.7	—
11.7	—	—	17.2	—	—	25.2	—	—	37.0	—	—	54.2	—	—	79.6	—	—
11.8	11.8	—	17.4	17.4	—	25.5	25.5	—	37.4	37.4	—	54.9	54.9	—	80.6	80.6	—
12.0	—	12	17.6	—	—	25.8	—	—	37.9	—	—	56.6	—	—	81.6	—	—
12.1	12.1	—	17.8	17.8	—	26.1	26.1	—	38.3	38.3	—	56.2	56.2	56	82.5	82.5	82
12.3	—	—	18.0	—	18	26.4	—	—	38.8	—	—	56.9	—	—	83.5	—	—
12.4	12.4	—	18.2	18.2	—	26.7	26.7	—	39.2	39.2	39	57.6	57.6	—	84.5	84.5	—
12.6	—	—	18.4	—	—	27.1	—	27	39.7	—	—	58.3	—	—	85.6	—	—
12.7	12.7	—	18.7	18.7	—	27.4	27.4	—	40.2	40.2	—	59.0	59.0	—	86.6	86.6	—
12.9	—	—	18.9	—	—	27.7	—	—	40.7	—	—	59.7	—	—	87.6	—	—
13.0	13.0	13	19.1	19.1	—	28.0	28.0	—	41.2	41.2	—	60.4	60.4	—	88.7	88.7	—
13.2	—	—	19.3	—	—	28.4	—	—	41.7	—	—	61.2	—	—	89.8	—	—
13.3	13.3	—	19.6	19.6	—	28.7	28.7	—	42.2	42.2	—	61.9	61.9	62	90.9	90.9	91
13.5	—	—	19.8	—	—	29.1	—	—	42.7	—	—	62.6	—	—	92.0	—	—
13.7	13.7	—	20.0	20.0	20	29.4	29.4	—	43.2	43.2	43	63.4	63.4	—	93.1	93.1	—
13.8	—	—	20.3	—	—	29.8	—	—	43.7	—	—	64.2	—	—	94.2	—	—
14.0	14.0	—	20.5	20.5	—	30.1	30.1	30	44.2	44.2	—	64.9	64.9	—	95.3	95.3	—
14.2	—	—	20.8	—	—	30.5	—	—	44.8	—	—	65.7	—	—	96.5	—	—
14.3	14.3	—	21.0	21.0	—	30.9	30.9	—	45.3	45.3	—	66.5	66.5	—	97.6	97.6	—
14.5	—	—	21.3	—	—	31.2	—	—	45.9	—	—	67.3	—	—	98.8	—	—

Standard Resistance Values are obtained from the Decade Table by multiplying by multiples of 10. As an example, 12.1 can represent 1.21Ω, 12.1Ω, 121Ω, 1.21 kΩ, etc.

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